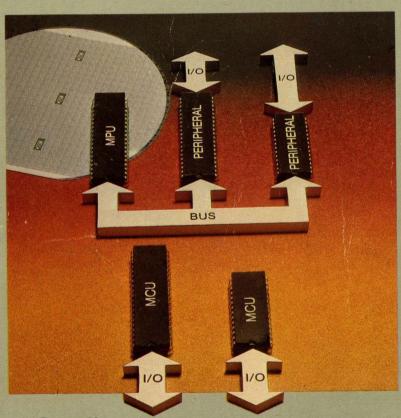


MOTOROLA MICROPROCESSORS DATA MANUAL



- Quality
- Reliability
- Technology

| Motorola's Microprocessor/Microcomputer Families |
|---|
| The Motorola M6800 Generic Bus Concept and Use |
| Reliability |
| Data Sheets |
| Mechanical Data |
| Technical Training |

Memory Products

Development Systems and

Board-Level Products

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Prepared by Technical Information Center

This book is intended to provide the design engineer with the technical data needed to completely and successfully design a microprocessor or microcomputer based system. The data sheets for Motorola's microprocessor, microcomputer, and peripheral components are included.

The information in this book has been carefully checked; no responsibility, however, is assumed for inaccuracies. Furthermore, this information does not convey to the purchaser of microelectronic devices any license under the patent rights of the manufacturer.

Additional information about memory products, technical training, and system development products is also provided. For further marketing and applications information, please contact:

Motorola Inc. MOS Integrated Circuits Group Microprocessor Division Austin, Texas (512)928-6800

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| MC3482/MC6882 | Quad Buffer/Latch | 4-28 |
| MC3870 | 8-Bit Single-Chip Microcontroller | 4-32 |
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| MC6805U2 | 8-Bit HMOS 2K Single-Chip Microcomputer | 4-243 |
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| MC6821 | Peripheral Interface Adapter | |
| MC6822 | Industrial Interface Adapter | |
| MC6828 | Priority Interrupt Controller | |
| MC6829 | Memory Management Unit | |
| MC6835 | CRT Controller | |
| MC6839 | Floating-Point ROM | |
| MC6840 | Programmable Timer | |
| MC6843 | Floppy-Disk Controller | |
| MC6844 | Direct Memory Access Controller | |
| MC6845 | CRT Controller | |
| MC6846 | ROM-I/O-Timer | |
| MC6847 | Video Display Generator | |
| MC6850 | Asynchronous Interface Adapter | |
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| MC6855 | Serial Direct Memory Access Processor | |
| MC6859 | Data Security Device | |
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| MC6870A/71A | Two-Phase Microprocessor Clock | |
| MC6875 | Two-Phase Clock Generator | |
| MC6880A/8T26 | Quad Bus Transceiver | |
| MC6883 | Synchronous Address Multiplexer | |
| | Quad Bus Transceiver | |
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ALPHANUMERICAL INDEX

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| MC141200 | 4-Bit CMOS 1K Microcomputer | 4-968 |
| MC146805E2 | 8-Bit CMOS Microprocessor with RAM and I/O | 4-985 |
| MC146805F2 | 8-Bit CMOS 1K Single-Chip Microcomputer | 4-1019 |
| MC146805G2 | 8-Bit CMOS 2K Single-Chip Microcomputer | 4-1021 |
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| MC146823 | CMOS Parallel Interface | 4-1066 |

Motorola's Microprocessor/Microcomputer Families

MOTOROLA'S MICROPROCESSOR AND MICROCOMPUTER FAMILIES

Serving as the "heart" of every microcomputer system is a microprocessor. Start with the chip set that precisely meets your design objective. Motorola manufacturers the industry's most complete selection of sold-state microcomputer components to give you the performance you need and the design flexibility you want.

The family concept has been extremely popular in the microprocessor industry. Motorola pioneered this family concept with the introduction of the M6800 Family in 1974. Since then the MPU/MCU Family has evolved in several directions, as shown in Figure 1-1, in order to fill expanding use concepts. In addition, the basic M6800 Family has been enhanced. A large number of peripheral devices have been developed to support the expanding family of microprocessors and microcomputers.

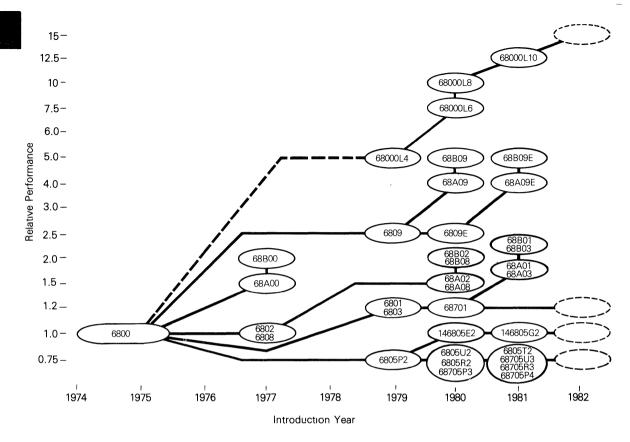
8-BIT MICROPROCESSORS (MPUs) MC6800 — MC6802 — MC6803 — MC6808 — MC6809 — MC6809E — MC146805E2

The MC6800 MPU was the first of the M6800 MPU Family and still remains a highly cost-effective processor for a great many process-control and data-communications applications. Seventy-two instructions and six different addressing modes give it powerful capability, and a full range of compatible peripheral chips offer the widest possible latitude in system implementation. After years of field experience, the MC6800 has earned an enviable reputation as one of the easiest-to-use processors available.

Moreover, to tailor the system to your specific needs at the lowest cost, the MC6800 (and its peripherals) is available in three different packages, three different temperature ranges, and three speed ranges, as follows:

| | | 1.5 MHz | | 1.5 | 2 MHz | |
|---------|-----------|--------------|-----------------|-----------|-------------|-----------|
| | 0 to 70°C | -40 to +85°C | - 55 to + 125°C | 0 to 70°C | -40 to 85°C | 0 to 70°C |
| Plastic | MC6800P | MC6800CP | _ | MC68A00P | MC68A00CP | MC68B00P |
| Cerdip | MC6800S | MC6800CS | MC6800BQCS | _ | _ | _ |
| Ceramic | MC6800L | MC6800CL | _ | MC68A00L | MC68A00CL | MC68B00L |

FIGURE 1-1. GENEALOGY OF THE COHESIVE M6800 MICROPROCESSOR/MICROCOMPUTER FAMILY



The MC6802 MPU has all the attributes of the basic MC6800, but it reduces the component count of a minimum microcomputer system to only two.

The MC6802 adds an on-chip clock oscillator and 128 bytes of RAM to the capability of an MC6800. Data in the first 32 bytes of the built-in RAM can be retained in a low-power mode by an external power source, allowing memory retention during a power-down situation.

Using this microprocessor, a minimum microcomputer system consists of:

- 1 MC6802 Microprocessing Unit
- 1 MC6846 ROM-I/O-Timer Unit

Of course, the system is expandable to any requirement with the adapters, expanders, and other peripheral chips that are a part of the M6800 Family.

The MC6802 is available in both ceramic (suffix L) and plastic (suffix P) packages.

The MC6803 MPU is the microprocessor version of the MC6801 singlechip microcomputer. The MC6803 accompdates applications where external ROM is present. With 13 parallel input/output lines, a 16-bit timer, and a serial communications interface the MC6803 offers a great deal of freedom in system needs. One of the most desirable attributes of the multigeneration MC6803 is its compatibility with existing software and hardware. The MC6803 easily meets this goal by being thoroughly integrated into the total M6800 family of components. In addition, since the MC6803 is an HMOS device, it requires only a single +5 volt power supply and interfaces with both TTL and MOS peripherals. The concept of an integrated family of devices is predicated on continuity in both design and development. As a member of the M6800 family, the MC6803 shares many of the attributes of the basic MC6800 MPU. For example, the MC6803 encompasses the full MC6800 instruction set, yet new instructions have been incorporated for even greater system capability and ease of programming. Many MC6803 instructions execute in fewer cycles than on the MC6800. More and faster instructions increase throughput and reduce software conversion and development time. Some of the features of the MC6803 are:

- Expanded MC6800 Instruction Set
- Full Duplex Serial Communications Interface
- Upward MC6800 Source and Object Code Compatibility
- 16-Bit Timer with Three Modes
- 16-Bit Multiplexed Address Bus Providing 64K-Byte Memory Space
- 128 Bytes of On-Chip RAM (64 Bytes Retainable with Battery Backup)
- 13 Parallel I/O Lines
- Internal Clock (Divide-by-Four)
- TTL-Compatible Inputs and Outputs
- Interrupt Capability (Maskable and Non-Maskable)

The MC6808 low-cost version of the MC6802 microprocessor has an on-chip clock oscillator and driver, but no on-chip memory. The MC6808 can use up to 64K of external RAM, ROM, or peripherals.

The MC6809 microprocessor, with five internal 16-bit registers, offers up to five times higher performance than the MC6800, yet, due to the 8-bit bus is fully compatible with all M6800 bus-oriented supplementary circuits and peripherals. Here's how the MC6809 stacks up:

Architectural Improvements:

- Additional 16-Bit Index and Stack Registers
- Direct Page Register
- Increased Addressing Modes

- 16-Bit Operations and 16-Bit Accumulator
- 8 x 8 Multiplier
- Fast Interrupt

Software Improvements:

- Designed for efficient handling of high-level languages, including Pascal, Basic, MPL, Cobol, and Fortran.
- Position-independent coding and reentrant-programming capability encourage development of "canned software," with modular program interchangeability.
- Structural, high subroutined code enhanced by two 16-bit index registers and program counter usable for indexing.
- Multi-task and multi-processor organization.
- Stack-oriented compiler instructions with both user and hardware stack registers available.

Although the MC6809 is compatible with the extensive existing M6800 Family, Motorola is designing even more peripherals to enhance systems designed with the MC6809. These new peripherals (e.g., the MC6829 Memory Management Unit, the MC6839 Floating Point ROM, and the MC6855 Serial DMA Processor) allow an MC6809 user to realize the full potential of the processor.

The MC6809 is a logical step for applications that crowd the capacity limits of today's conventional 8-bit processor — yet, hardware and software (upward) compatibility with existing M6800 processors protects previous software investment.

The MC6809E includes all the features of the MC6809 plus external clocking to provide the flexibility required in a multi-processor system.

The MC146805E2 initiates the CMOS side of Motorola's microprocessor family. Battery-oriented and noise sensitive applications have long sought an M6800 MPU implemented in CMOS. The MC146805E2 includes an 8-bit optimized processor the equal of the MC6800 in speed and performance, plus on-chip RAM, timer, parallel I/O ports, and clock oscillator. Complete CMOS systems are assembled using the MC146823 Parallel Interface, MC146818 Real-Time Clock plus RAM, MCM65516 CMOS 2K ROM, and many MSI and SSI support parts. The MC146805E2 also serves as a ROMless prototype device for the CMOS and HMOS M6805 Family single-chip MCUs.

The processor has sixty-one basic instructions that are similar to those of the popular MC6800 microprocessor, plus some unique enhancements. A complete set of bit-manipulation and test instructions allow any bit in RAM or any I/O pin to be individually set or cleared or tested as a conditional branch, all with a single instruction. The table look-up indexing modes have also been enhanced and made more ROM efficient.

The very low power requirement of static CMOS make the MC146804E2 family of processors and peripherals extremely attractive for those applications where power is a major consideration (portable instruments, telecommunications, point-of-sale terminals, remote instrumentation, industrial control, applicance controllers, etc.). The operating voltage range is from 3 to 6 volts, while current usage ranges from microamps upward depending upon frequency, voltage, standby modes, and operating duty cycle. Other MC146805E2 features include:

- Expansion Bus Addressing 8K Bytes of Memory
- 112 Bytes of RAM
- 16 Bidirectional I/O Lines in Addition to the Bus
- 2 Program Initiated Low-Power Standby Modes
- Timer/Counter:
 - 8-Bit Programmable Counter
 - 7-Bit Software-Selectable Prescaler
 - External Timer Input
 - Maskable Timer Interrupt
- Maskable External Interrupt
- 40-Pin Package
- Fully Static Operation for Lower Power Needs
- Oscillator Frequency to 5 MHz at 5 V
- Compatible ROM Available MCM65516 (2K x 8)

8-BIT MICROPROCESSORS FEATURES MATRIX

| Device | Tech | Pins | RAM 8X | I/O Lines | Special I/O | Mnem Inst ¹ | Ext Addr | Data Size | Clock | Timer |
|------------|------|------|-----------|--------------|----------------|---------------------------|-------------|--------------|-------|-----------|
| MC6800 | NMOS | 40 | _ | _ | _ | 72 | 64K | 8 | No | _ |
| MC6802 | NMOS | 40 | 128 | | _ | 72 | 64K | 8 | Yes | _ |
| MC6802NS | NMOS | 40 | 128 | _ | _ | 72 | 64K | 8 | Yes | _ |
| MC6803 | HMOS | 40 | 128 | 13 | Serial | 82 | 64K | 8 | Yes | 16-Bit |
| MC6803NR | HMOS | 40 | _ | 13 | Serial | 82 | 64K | 8 | Yes | 16-Bit |
| MC6808 | HMOS | 40 | - | _ | _ | 72 | 64K | 8 | Yes | _ |
| MC6809 | HMOS | 40 | - 1 | _ | <u> </u> | 59 | 64K² | 8 | Yes | _ |
| MC6809E | HMOS | 40 | _ | _ | _ | 59 | 64K² | 8 | No | _ |
| MC146805E2 | CMOS | 40 | 112 | 16 | _ | 61 | 8K | 8 | Yes | 8-Bit + |
| | | | | | | | | | | Prescaler |

NOTES:

- Some Mnemonic Instructions can have many Opcode Instructions. As a result a Microprocessor normally has many more Opcode Instructions than Mnemonic Instructions. For instance the MC6809 has 59 Mnemonic Instructions and 1464 Opcode Instructions.
- 2. Two megabytes when used with the MC6829 Memory Management Unit.

8-BIT MICROPROCESSORS SELECTOR GUIDE

| | TECH | NOLOGY | PROCESSING POWER | | | | |
|---|---|---|---|---|--|---|------------------------|
| HMOS/NMOS MC6800 MC6802NS MC6803NR MC6803NR MC6808 MC6809 | Page 4-55 4-125 4-125 4-84 4-84 4-125 4-266 4-298 | CMOS MC146805E2 | Page 4-985 | MC6 MC6 MC6 MC6 MC6 | 800 802 802NS 803NR 803NR 808 | Page 4-55 4-125 4-125 4-84 4-84 4-125 4-266 4-298 4-985 | |
| FUNC | TIONA | L BLOCKS | | LANG | UAGE (| PRIENTATI | ON |
| MPU MC6800 MC6803NR MC6808 MC6809 MC6809E | Page 4-55 4-84 4-125 4-266 4-298 | MPU with On-Chip RAM MC6802 MC6802NS MC6803 MC146805E2 | Page 4-125 4-125 4-84 4-985 | Low-Level Language MC6800 MC6802 MC6802NS MC6803 MC6803NR MC6808 MC146805E2 | Page 4-55 4-125 4-125 4-84 4-84 4-125 4-985 | High-Level Language MC6809 MC6809E | Page 4-266 4-298 |

SINGLE-CHIP MICROCOMPUTERS (MCUs) THE M6801 — M6805 — M3870 — M141000 FAMILIES

Take a basic MPU; add an on-chip clock oscillator and timer; put in enough Read-Only Memory (ROM) to handle the program routines for dedicated application, and enought Ready/Write (RAM) Memory capacity to handle the associated data manipulations; cap it off with sufficient input/output capability to interface with a number of parallel and serially oriented peripherals and you have a single-chip microcomputer.

The single-chip system doesn't necessarily have all the flexibility of a multi-chip system, but with adequate capacity to handle a specific requirement, it can save both component cost and equipment manufacturing cost.

Motorola offers single-chip microcomputers across a broad spectrum of processor performance and system functionality. Motorola's first high volume production single-chip MCU is the second source of the popular 3870. The 4-bit CMOS M141000 Family includes two ROM-based parts, plus a ROM-less version. The M6801 Family includes the high performance single-chip MCU, plus EPROM and ROM-less versions. The rapidly expanding M6805 Family includes a number of memory and package sizes with various special I/O functions, in both HMOS and CMOS.

PERFORMANCE — Processor performance, or program efficiency, for the application is an important single-chip MCU selection criteria. The M6801 Family is the throughput leader with 16-bit data operations, binary multiply, and an average of only 3.7 cycles per instruction. Bit modify and test instructions and powerful indexing modes put the M6805 Family in second place on the performance scale. The MC3870 offers a very successful 8-bit architecture, while the M141000 Family parts are clasic 4-bit processors.

TECHNOLOGY — The very high production volumes of high-density NMOS (HMOS) permit low cost single-chip solutions. CMOS, as a relatively new microcomputer technology, offers very low power consumption and wide power supply tolerance at performance levels similar to HMOS. The M6801 Family, M6805 Family, and MC3870 are produced in HMOS while the M6805 and M141000 Families make CMOS benefits available. The M6805 Family is the first microcomputer that allows you to look at the technology trade-offs independent of the architectural and supplier choices.

ROM SIZE — The mask ROM capacities of the present single-chip MCUs range from 1K bytes for the M6805 and the M141000 Families up to 2.5K bytes on one M6805 Family version. However, the M6801 and M6805 Families may in the future be implemented with as much as 64K bytes of on-chip ROM without any architectural changes. In selecting the ROM size, the ROM usage efficiency of the instruction set should be considered, along with the application to be programmed. Architectures of the M141000 and MC3870 class offer short one and two byte instructions. The M6801 and M6805 Families use many multi-function instructions such as

bit manipulation, memory modification, indexing, and multiply to do the function of two or more instructions in traditional MCUs.

NON-MASK-ROM VERSIONS — EPROM versions and/or ROM-less versions of practically all single-chip MCUs are offered. They serve for limited volume applications, prototype debugging, and field trials. EPROM versions are available in the M6805 and M6801 Families. ROM-less versions are offered in the M6801, M6805, and M141000 Families.

RAM SIZE — On-chip RAM sizes range from 32 bytes in the M141000 Family (organized as 64 nibbles) to 128 bytes in the M6801 Family. Between these present limits are the M6805 Family versions and the M3870 at 64 bytes and 112 bytes. Architectures such as the M6801 and M6805 Families which permit multi-level subroutines plus ROM and RAM data tables allow you to trade-off ROM and RAM utilization. ROM usage can be minimized with subroutines and look-up tables, while RAM use can be optimized with ROM tables and fewer subroutines.

DIGITAL I/O — Single-chip MCUs are available in 40-pin dual-in-line packages as well as the smaller (and lower cost) 28-pin packages. All four MCU families include 40-pin versions, while the M6805 and M141000 Families also have 28-pin members. Five to seven pins serve power and control functions permitting up to 23 I/O pins in a 28-pin package and up to 34 I/O pins in 40-pin versions (including interrupts, timers, and special I/O functions). The M141000 Family has four dedicated input pins, with all other I/O pins being outputs. All of the other MCUs offer essentially any mix of inputs and outputs. Higher output drive current is available in the M6805 and M141000 Families.

EXPANSION BUS — The ROM-less versions include a bus to access off-chip program memory and additional I/O. However, the M6801 Family single-chip MCUs also include three bus structure modes for off-chip expansion. The three bus modes permit the number of bus pins to be optimized for the amount of address space needed off-chip.

INTERRUPTS — When an application program must synchronize to two or more external events, interrupt hardware in some form is usually necessary. The M6801 and M6805 Families include fully automatic interrupts (registers are saved) with programmable vectors for both external pins and internal timers. The MC3870 interrupt scheme requires more program overhead. The M141000 Family serves the straight forward applications that do not need interrupts.

TIMERS — On-chip timers are the most frequently used special I/O function. Timers may generate interrupts to a program at a periodic rate, may measure external values, may count external events, and may generate measured output values. The M6801 Family includes a 16-bit timer that may be used to perform three of the above functions simultaneously. The M6805 Family timer consists of a programmable 8-bit counter and a selectable 7-bit prescaler. The MC3870 timer is 8 bits with a decimal prescaler. The M141000 Family does not include on-chip timers.

SPECIAL FUNCTIONS — Various members of the MCU families include additional I/O functions. For example, the MC6801 Family includes a full 8-bit UART with baud rate generator on-chip. A 4-channel 8-bit A/D converter is included on a few M6805 Family versions. A 7-segment display decoder is included on the M141000 Family parts. The digital portion of an RF frequency synthesizer is added to an M6805 Family member.

DEVELOPMENT SUPPORT — All four families are fully supported on the EXORciser development system. Included are assemblers, keyboard debugging including breakpoints, user system emulation, and stand-alone emulation. The M6801 Family has the added benefit of various high level languages and compatibility with MC6800 programs.

THE CMOS M6805 COMPONENTS

Motorola offers an 8-bit CMOS processor in the MC146805E2. The CMOS portion of the M6805 Family of 8-bit microprocessors, peripherals, and single-chip microcomputers combines the low power characteristic of CMOS, with the application flexibility of the M6800 Family.

The M6805 Family has evolved from the M6800 Family. The M6805 Family includes similar programmable bidirection I/O, flexible memory organization, many memory reference instructions, interrupts, and multi-level subroutine nesting. ROM use efficiency, bit manipulation instructions, and improved table look-up indexing are M6805 Family enhancements of the M6800 heritage.

The benefits of CMOS are added to Motorola's microprocessor repertiore. Low operating power, and even lower standby power consumption, permit battery operation, cut cooling costs, and reduces power supply expense. The wider operating voltage range of CMOS offers higher noise immunity and easier switching to standby power. Static CMOS parts permit true standby operation plus power optimization with lower frequencies and voltages.

PROGRAMMING — The enhanced M6800 architectural features make the M6800 Family easy to program. The stack pointer permits up to 32 subroutine levels. Three ROM-efficient indexed addressing modes allow for look-up tables anywhere in memory. Any I/O pin or RAM bit may be modified with a single instruction. A branch may be taken depending upon the bit state of any I/O pin or RAM bit with only a single instruction. RAM, ROM, and I/O registers are all accessed with the same powerful memory addressing instructions. An efficient instruction set permits programs to be written faster, more easily optimized, and, therefore, more reliable.

INTERRUPTS — Real-time applications require sensing, measuring, and controlling system events. Five vectored interrupts, which stack the program registers, are included in M6805 Family processors to implement these applications. For time dependent tasks, a programmable 8-bit counter generates an interrupt when zero is reached. The timer includes a program-selectable 7-bit prescaler and a software selectable input. The timer input may be an external signal, pulse width measurement, or the on-chip oscillator. An external interrupt pin is also provided. Software techniques for external event synchronization are not needed.

MOTEL — The MOTEL concept (for MOtorola and InTEL bus compatibility) allows both types of processors to be interchanged on a bus without changing the design of the peripheral/memory system. The MOTEL circuit automatically detects which type of processor is connected, and interprets the bus control signals appropriately. The MCM65516 2K CMOS ROM, MC146818 Real-Time Clock plus RAM, and MC146823 Parallel Interface incorporate the MOTEL concept to provide a high degree of system flexibility.

SINGLE-CHIP MICROCOMPUTERS — Dedicated single-chip MCUs are also included in the M6805 Family. The MC146805F2 has 1K bytes of onchip ROM, while the MC146805G2 has a 2K ROM. The MC146805G2 also includes 112 RAM bytes, 32 input/output lines, programmable timer, external and timer interrupts, and high current output pins. The 1K MC146805F2 has the same interrupt features but fewer I/O lines, 28 pins, and a smaller RAM, 64 bytes. The MC146805E2 microprocessor serves as the ROM-less prototyping part for both single-chip MCUs.

PERIPHERALS — Two types of CMOS peripherals are being added to Motorola's CMOS family. Parallel bus-oriented peripherals support microprocessors such as the MC146805E2, while single-chip microcomputers are supported by port-oriented I/O, usually using serial data transfer. The MC146823 Parallel Interface offers three 8-bit ports (24 lines) of digital interfacing, including port latch control signals, to multiplexed-bus microprocessors such as the MC146805E2. The MC146818 Real-Time Clock

plus RAM relieves the processor of maintaining the time and date, generates timed interrupts, and includes 50 bytes of CMOS RAM. Program memory is provided by the completely bus compatible MC65516 2K CMOS ROM. Other support circuits include LCD drivers (MC145000, MC145001, MC144115, and MC144117), LED drivers (MC14499 and MC144100), D/A converters (MC144110 and MC144111), A/D subsystem (MC14443 and MC14447), latches (MC14099, MC14597, MC14598, and MC14599), remote I/O (MC14469) and frequency synthesizers (MC14156 and MC145144).

POWER SAVINGS — Energy efficiency is, of course, the chief CMOS attraction. CMOS MPUs are seriously considered anywhere a battery is used, whether it be the primary or a back-up power source. The operating current can be orders-of-magnitude lower. Standby modes can have power usages order-of-magnitude lower yet. Since the M6805 Family is static in design, low-speed operating current is extremely low.

STATIC DESIGN — The clock of a static CMOS microprocessor may be at any frequency below the specified maximum. CMOS users frequently lower the frequency, to conserve power, approaching the point where the processor is fully loaded during the worst-case program cycle. A static MPU allows operation at 1 kHz or 10 kHz in applications where battery drain is critical, and the work load light. A static processor can also be stopped during any cycle without losing any volatile information, which assures extremely low standby current.

PROGRAM CONTROL OF POWER — Typical CMOS microprocessor applications require considerable attention to minimizing power consumption. The M6805 Family CMOS processors include program control of power usage, as well as the traditional external power optimizing tools. The program may initiate either of two standby modes, called Stop and Wait, which halt program execution. The external or timer interrupts automatically turn the processor back on to allow execution to resume. Why not save power when the program has no work to do? The program can be restarted when there is work that needs doing. Battery drain is the average of operating and standby current for the average work duty cycle.

LOW POWER DISSIPATION — A major side benefit of low power usage is that the heat dissipated is also low. The costs of cooling equipment is not needed. Fan noise in an office environment, as well as fan unreliability, need not be endured. Systems may be enclosed in smaller housings. Air tight systems need not have special heat conducting mechanisms.

WIDER VOLTAGE RANGE — The initial CMOS MPU products are characterized to operate from 3.0 to 6.0 voltages. The voltage range is being extended to higher voltages in upcoming versions. The wider voltage range permits lower cost power regulation, easier switching to back-up sources, and lower cost batteries. The higher voltage parts add noise immunity to the wide voltage range benefits.

SINGLE-CHIP MICROCOMPUTER FAMILIES FEATURES MATRIX

| | | 141000 Family | | | | M6805 Family | | | | | |
|---------------|--------------------|---------------------|-----------------|-------------|---------------|--------------------------------|-------------------|-------------------|-------------------|------------|--|
| | | MC141000 | MC141200 | MC141099 | MC3870 | MC6805P2 | MC6805P4 | MC6805U2 | MC6805R2 | MC6805T2 | |
| | Bits | | 4 Bits | <u> </u> | 8 Bits | | | 8 Bits | | | |
| | Instruction Set | TMS1000 | | | F8 | Control Optimization of MC6800 | | | | | |
| Processor | Registers | 7 Special Registers | | | 7 Registers | | 2 General Purp | ose and 3 Spec | ial Registers | | |
| | Addressing Modes | 5 Addressing Modes | | | 5 Addr Modes | | 10 / | Addressing Mode | es . | | |
| | Basic Inst Types | | Basic Inst Ty | | 54 Basic Inst | | 59 Ba | sic Instruction T | ypes | | |
| | Total Instructions | | Total Instruct | | 76 Total Inst | | 207 | Total Instruction | ns | | |
| | μs/Avg inst | | Instruction (6) | | 4.7 μs/Inst | | 4.9 to 5.4 μs po | er Average Instr | uction (1 MHz) | | |
| | Subroutines | 1 | Subroutine Le | vel | 1 Level | | 13 | Subroutine Leve | ls | | |
| Technology | | | CMOS | | NMOS | | | HMOS | | | |
| | Mask ROM | 1K ROM | 1K ROM | No ROM | 2K ROM | 1K ROM | 1K ROM | 2K ROM | 2K ROM | 2.5K ROM | |
| Memory | EPROM | - | _ | _ | _ | - | _ | - | - | _ | |
| | RAM Bytes | 32 RAM | 32 RAM | 32 RAM | 64 RAM | 64 RAM | 112 RAM | 64 RAM | 64 RAM | 64 RAM | |
| Package Size | | 28 Pins | 40 Pins | 48 Pins | 40 Pins | 28 Pins | 28 Pins | 40 Pins | 40 Pins | 28 Pins | |
| | Inputs | 4 Inputs | 4 Inputs | 4 Inputs | _ | | _ | 8 Inputs | 2 to 5 ln | _ | |
| Input/ | Outputs | 19 Outputs | 24 Outputs | 21 Outputs | _ | - | - | _ | - | - | |
| Output | Mask Bidir | | _ | | 32 1/0 | _ | - | - | - | _ | |
| Pins | Prog Bidir | - | _ | _ | _ | 20 1/0 | 20 1/0 | 24 1/0 | 24 1/0 | 19 1/0 | |
| | Spec. Func | - | - | - | _ | - | - | - | 1 to 4 Analog | 2 Special | |
| Expansion Bus | | _ | _ | To ROM, PLA | _ | _ | | _ | _ | _ | |
| | Display Decoder | 7-Segm | ent PLA | _ | | | | | | | |
| Special | High Current Drive | 20 | mA, All Outp | uts | _ | • | 10 n | nA Drive on 8 P | ins | | |
| Function | Analog Inputs | - | _ | _ | _ | - | _ | _ | 8-Bit A/D | _ | |
| 1/0 | Serial I/O | - | _ | _ | - | Shi | ft Register I/O w | nth Bit Manipula | ation Instruction | S | |
| | Frey Synth | _ | | | | | | | | Freq Synth | |
| Standby RAM | | - | _ | _ | _ | - | Stby. RAM | _ | _ | _ | |
| | Prescale Bits | | | | ÷200 Prescale | | 7 | Prescaler Bits | | | |
| Timer | Counter Bits | l | No Timer | | 8-Bit Counter | 1 | | 8-Bit Counter | | | |
| | Timer Functions | 1 | | | 1 Function | l | 1 Time | r Function at a | Time | | |
| | Timer Interrupt | | | | Timer IRQ or | | T | imer Interrupt | | | |
| Interrupts | External IRQ | ł | No Interrupts | | 1 Ext IRQ | 1 E | xt IRQ | 2 Ext | IROs | 1 Ext IRQ | |
| | Serial I/O IRQ | | | | | <u> </u> | | | | | |
| | ICs | RO | OM-Less Versi | on | _ | | | nd ROM-Less Ve | ersions | | |
| Development | Dev System | 1 | EXORciser® | | EXORciser® | l | | EXORciser® | | | |
| Support | Emulation | User | System Emu | ator | USE | 1 | User | System Emulate | or | | |
| Cupport | Assembler | 1 | Assembler | | Assembler | 1 | М | acro Assembler | | | |
| | HL Language | | | | _ | | | | | | |

SINGLE-CHIP MICROCOMPUTER FAMILIES SELECTOR GUIDE

| | TECHNO | LOGY | | PROCESSING POWER | | | | | |
|--|---|--|--------|---|---------------------------------|--|--------|--|--|
| HMOS/NMOS MC6805P2 MC6805P4 MC6805R2 MC6805T2 MC6805U2 MC68705P3 MC68705R3 MC68705U3 MC3870 | Page 4-146 4-168 4-191 4-216 4-243 4-894 4-918 4-945 4-32 | CMOS MC141000 MC141099 MC141200 MC146805E2 MC146805F2 MC146805G2 | 4-1019 | 4-Bit MC141000 MC141099 MC141200 | Page 4-968 4-968 4-968 | 8-Bit MC6805P2 MC6805P4 MC6805R2 MC6805T2 MC6805U2 MC68705P3 MC68705R3 MC68705U3 MC3870 MC146805E2 MC146805E2 | | | |
| | | | | | | MC146805G2 | 4-1021 | | |

| | | MC6805 Fam | ily (continued) | | | | M6801 Family | | | | | |
|-----------------------|-----------------------------|------------------|-----------------|-------------------|------------|---------------------------|----------------------|--------------|--------------------|---------------|--|--|
| MC68705P3 | MC68705U3 | MC68705R3 | MC146805G2 | MC146805F2 | MC146805E2 | MC6801 | MC68701 | MC6803 | | | | |
| | | 8 B | ıts | | | | 8 Bits | | Bits | | | |
| | Co | ontrol Optimizat | ion of MC6800 | | | s | uper Set of MC680 | 10 | Instruction Set | | | |
| | 2 Gene | eral Purpose and | 1 3 Special Reg | isters | | 2 (| General, 4 Special F | leg. | Registers | | | |
| | | 10 Address | ing Modes | | | | 7 Addressing Mode: | S | Addressing Modes | Processor | | |
| | instruction Ty | | | l Basic Inst Typ | | | 75 Basic Inst Type: | | Basic Inst Types | FIOCESSOI | | |
| | otal Instruction | | | 9 Total Instructi | | | 19 Total Instruction | | Total Instructions | | | |
| .9 to 5.4 μ s per | | | | 4.0 μs/Avg Inst | | 3. | 7 μs/Avg Inst (1 M | Hz) | μs/Avg Inst | | | |
| 13 Sc | ubroutine Levels | | 29 Levels | 13 Levels | 29 Levels | <u> </u> | Indefinite Levels | | Subroutines | | | |
| | HMOS | | | CMOS | | | HMOS | | | Technology | | |
| - | - | - | 2K ROM | 1K ROM | No ROM | 2K ROM | _ | No ROM | Mask ROM | | | |
| 1.8K EPROM | 3.8K EPROM | 3.8K EPROM | - | - | - | - | 2K EPROM | - 1 | EPROM | Memory | | |
| 112 RAM | 112 RAM | 112 RAM | 112 RAM | 64 RAM | 112 RAM | 128 RAM | 128 RAM | 128 RAM | RAM Bytes | | | |
| 28 Pins | 40 Pins | 40 Pins | 40 Pins | 28 Pins | 40 Pins | 40 Pins | 40 Pins | 40 Pins | | Package Size | | |
| - | 8 Inputs | 2 to 5 ln | - | 4 Inputs | - | - | _ | | Inputs | | | |
| - | - | - | - | - | - | - | - | - | Outputs | Input/ | | |
| - | - | - | - 1 | - | - | - | - | - | Mask Bidir | Output | | |
| 20 1/0 | 24 1/0 | 24 1/0 | 32 1/0 | 16 1/0 | 16 1/0 | j | 24 to 31 I/O | | Prog Bidir | Pins | | |
| | L | 1 to 4 Analog | _ | | | 0 to 7 Special Funct Pins | | | Spec. Func | | | |
| _ | _ | | _ | | 8K Addr | | 64K Addressability | | | Expansion Bus | | |
| _ | - | - | _ | - | _ | - | - | - | Display Decoder | | | |
| 10 | mA Drive on 8 | | 10 mA, 4 Pins | _ | _ | - | - | - | High Current Drive | Special | | |
| - | - | 8-Bit A/D | - | _ | - | - | - | - | Analog Inputs | Function | | |
| | Shift Regist | er I/O with Bit | Manipulation In | structions | | 8-B | it UART+Bit Rate | Serial I/O | 1/0 | | | |
| | | | | | _ | | | | Freq Synth | | | |
| | _ | | | | | - | | - | | Standby RAM . | | |
| | | 7 Pres | caler Bits | | | - | _ | - | Prescale Bits | | | |
| | | 8-Bit | Counter | | | | 16-Bit Timer | | Counter Bits | Timer | | |
| | | 1 Timer Fund | tion at a Time | | | 3 Sim | ultaneous Timer Fu | nctions | Timer Functions | | | |
| Timer | | | Interrupt | | | | 3 Timer Interrupts | | Timer Interrupt | | | |
| 1 Ext IRQ 2 Ext IRQs | | | 1 Ext IRQ | | | 2 Ext Interrupts | | External IRQ | Interrupts | | | |
| - | | | | | | | 2 Serial I/O IRQs | | Serial I/O IRQ | | | |
| | EPROM and ROM-Less Versions | | | | | | | ersions | ICs | | | |
| EXORciser® | | | | | | | EXORciser® | Dev System | Development | | | |
| | | • | em Emulator | | | , " | lser System Emulat | or | Emulation | Support | | |
| | | Macro | Assembler | | | ł | Macro Assembler | | Assembler | Обрин | | |
| | | | | | | | Fortran, Basic, MPI | | HL Language | | | |

| FUNC | CTIONAL | BLOCKS | | LANGUAGE ORIENTATION Low-Level |
|-------------|---------|------------|--------|---------------------------------|
| MPU with | | | | Language Page |
| On-Chip RAM | Page | MCU | Page | MC6805P2 4-146 |
| MC141099 | 4-498 | MC6805P2 | 4-146 | MC6805P4 4-168 |
| MC146805E2 | 4-985 | MC6805P4 | 4-168 | MC6805R2 4-191 |
| | | MC6805R2 | 4-191 | MC6805T2 4-216 |
| | | MC6805T2 | 4-216 | M C6805U2 4-243 |
| | | MC6805U2 | 4-243 | MC68705P3 4-894 |
| | | MC68705P3 | 4-894 | MC68705R3 4-918 |
| | | MC68705R3 | 4-918 | MC68705U3 4-945 |
| | | MC68705U3 | 4-945 | MC3870 4-32 |
| | | MC3870 | 4-32 | MC141000 4-968 |
| | | MC141000 | 4-968 | MC141099 4-968 |
| | | MC141200 | 4-968 | MC141200 4-968 |
| | | MC146805F2 | 4-1019 | MC146805E2 4-985 |
| | | MC146805G2 | 4-1021 | MC146805F2 4-1019 |

16-BIT MICROPROCESSORS (MPUs) THE M68000 FAMILY AN INVESTMENT IN THE FUTURE

The family concept has been extremely popular in the Microprocessor industry. Motorola pioneered this family concept with the introduction of the M6800 Family in 1974. Led by the MC68000 Microprocessing Unit (MPU) in 1979 and followed by a host of peripherals, the M68000 Family offers the engineer a set of building blocks to construct cost-effective solutions to an ever-widening range of complex 16/32 bit applications. The tremendous popularity of the M68000 Family is not without warrant. HMOS technology, performance, and support are but a few of the many reasons why the M68000 Family continues to be the 16-bit industry leader.

It should be noted that the M68000 Family is a not-so-distant relative of the MC6800. All M6800 Family peripherals interface directly with the MC68000, so upward compatibility is built-in. Where lost cost and medium performance are required, they present a very attractive alternative. The plan for the M68000 Family is a simple one. Provide the marketplace with the best 16-bit family and back it up with support that is second to none. And it's happening now.

What about expandability? The M68000 Family is designed with this in mind. All the way from an internal microcoded 32-bit architecture to the third-generation EXORmacs development system. Efficient high level language support provided by Pascal allows upward compatibility of software from 8-bit to 16-bit to 32-bit machines.

The majority of today's 16-bit microprocessor applications are quite complex, with long design times. Clearly, the required investment in design resources requires finished products to have increased longevity. Motorola understands this, and is committed to offering a family which will allow these products to remain state-of-the-art for years to come. Thus, the M68000 Family is an investment in the future.

The following list represents the currently available 16-bit products. Contact your Motorola representative for additional information.

16-BIT PRODUCT LISTING

| Processor MC68000 — 16-Bit Microprocessing Unit | Page 4-661 |
|---|----------------------|
| Peripherals | |
| MC68120/121 — Intelligent Peripheral Controller | 4-711 |
| MC68122 — Cluster Terminal Controller | 4-755 |
| MC68230 — Parallel Interface/Timer | 4-783 |
| MC68450 — Memory Management Unit | 4-812 |
| MC68451 — Direct Memory Access Controller | 4-818 |

PERIPHERAL AND INTERFACE COMPONENTS

Motorola manufactures and is continuing in new design efforts to provide you with an extensive selection of efficient, cost effective peripheral and interface components.

PERIPHERAL AND INTERFACE COMPONENTS SELECTOR GUIDE

| For | FOR NMOS/HMOS MICROPROCESSOR SYSTEMS MC6800 Two-Phase Clock Generation | Page |
|-----|--|---------|
| | MC6870A, 6871A, 6871B — Two-Phase Microprocessor Clocks. | 4-605 |
| | MC6875 — Two-Phase Clock Generator | |
| For | Parallel-Oriented Applications | |
| | MC6821 — Peripheral Interface Adapter | 4-335 |
| | MC6822 — Industrial Interface Adapter | 4-345 |
| | MC6828 — Priority Interrupt Controller | 4-348 |
| | MC6840 — Programmable Timer | |
| | MC68488 — General Purpose Interface Adapter | 4-836 |
| For | Serial Applications | |
| | MC6850 — Asynchronous Interface Adapter | 4-527 |
| | MC6852 — Synchronous Serial Data Adapter | 4-536 |
| | MC6854 — Advanced Data Link Controller | 4-550 |
| | MC6855 — Serial Direct Memory Access Controller | 4-572 |
| | MC6860 — Digital Modem | 4-583 |
| | MC6862 — Digital Modulator | 4-597 |
| | MC68122 — Cluster Terminal Controller | 4-755 |
| For | Complex Peripheral Control | |
| | MC6829 — Memory Management Unit | 4-356 |
| | MC6835 — CRT Controller | 4-371 |
| | MC6839 — Floating Point ROM | 4-392 |
| | MC6843 — Floppy Disk Controller | |
| | MC6844 — Direct Memory Access | 4-441 |
| | MC6855 — Serial Direct Memory Access Processor | 4-572 |
| | MC6859 — Data Security Device | 4-574 |
| | MC68120/MC68121 — Intelligent Peripheral Controller | 4-711 |
| For | Television Display | |
| | MC1372 — Color TV Video Modulator | |
| | MC6847 — Video Display Generator | . 4-499 |

PERIPHERAL AND INTERFACE COMPONENTS SELECTOR GUIDE (CONTINUED)

| FOR SYSTEM EXPANSION | Page |
|---|--------|
| MC3446 — Quad Bidirectional Bus Transceiver | 4-13 |
| MC3447 — Octal Bidirectional Inst. Bus (GPIA) Transceiver | 4-16 |
| MC3448 — Quad Bidirectional Inst. Bus (GPIB) Transceiver | 4-22 |
| MC3482/MC6882 — Quad Buffer Latch | 4-28 |
| MC6880A/MC68T26 — Quad Bus Transceiver | 4-624 |
| MC6889/MC8T28 — Quad Bus Transceiver | 4-655 |
| FOR CMOS SYSTEMS | |
| MC146818 — Real-Time Clock plus RAM | 4-1046 |
| MC146823 — Parallel Interface | |

The Motorola M6800 Generic Bus Concept and Use

THE M6800 GENERIC BUS CONCEPT AND USE M6800 — M6801 — M6802 — M6809 — M6800 FAMILY PERIPHERALS

After more than 5 years of experience shipping many millions of microprocessors and peripherals, Motorola has collected, coordinated, and improved the bus timing parameters for these 8-bit devices. The smaller geometries and reduced capacitances obtained by introduction of optical reductions of existing mask sets, the use of new process techniques such as HMOS I and HMOS II, and the natural improvement in product yield that comes with experience have allowed Motorola to improve many performance parameters.

The new enhanced peripheral bus timing specifications allow their use in even wider ranges of applications and yet maintain complete compatibility with existing systems. This section provides a discussion about:

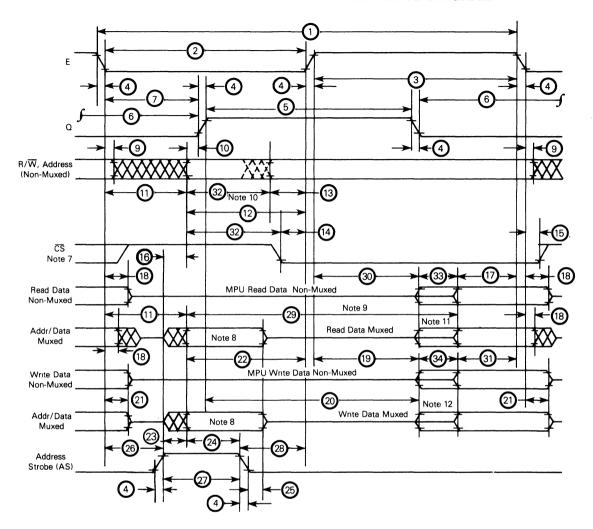
- The Generic Bus concept for both 8-bit NMOS/HMOS and CMOS devices.
- A complete set of bus timing for all of the 8-bit microprocessors (except the MC6800) and peripherals in one table (grouped by speed).
- A set of equations for calculating worst-case bus timing. These appear as notes under appropriate Generic Bus timing diagram.

The bus timing diagram shown in Figure 2-1 illustrates the waveforms needed for or generated by all but two of Motorola's mid-range family of 8-bit microprocessors and peripherals. (The MC6800, although it began the family, is not shown, due to the nature of the ϕ 1, ϕ 2, and DBE input signals.) A generic bus timing characteristics table gives a side-by-side comparison of major microprocessor types within the M6800 family, along with the input and output specifications common to all bus peripherals. These tables are shown as Tables 2-1 through 2-3.

A *subset* of the generic bus timing diagram and characteristics table appears in each data sheet (except the MC6800 and MCM6810) showing only the signals and identification numbers appropriate to that part.

A standard bus specification such as this allows a comparison of multiplexed and non-multiplexed processors; all timings associated with a particular system are shown together, which makes worst-case design easier.

FIGURE 2-1. NMOS/HMOS GENERIC BUS TIMING DIAGRAM



NOTES.

- 1 Not all signals are applicable to every part
- Voltage levels shown are V_L≤0 4 V, V_H≥2.4 V, unless otherwise specified
- 3 Measurement points shown are 0 8 V and 2 0 V, unless otherwise specified
- 4 For MC6800, write data is referenced to DBE, not E, see M6800 pages.
- 5. For MC6800, address delay is referenced to φ1, not E, see M6800 pages
- 6 Clock pulse rise and fall time for MC6800 measured to V_{CC} -0 6 V, see M6800 pages
- 7. CS and CS on MC6810 have same timing
- 8 Address valid on the occurrence of the latest of 11, 12, 16, 22, or 23
- 9 Usable access time is computed by 1 (4+11+17), or 12+4-17, see note 8 (except for MC6809, for MC6809, by 1-4-7 max +10-17)
- Usable address buffer time is computed by 2-(11+13), see note 8 (except for MC6809, for MC6809, by. 2-7 max+10-13).
- 11 Usable read data buffer time is computed by 3 (17 + 30)
- 12 Usable write data buffer time is computed by: 3 (19+31), except for MC6809; for MC6809, by: 1 (4+7 max+4+20+31)

TABLE 2-1. NMOS/HMOS GENERIC BUS TIMING CHARACTERISTICS FOR 1.0 MHz OPERATION

| ldent. | | | 6800 | | 6801 | | 6802 | | 6809 | | 6821/ 6859 | | |
|--------|---|---------------------|------|----------|------|------|------|------|------|------|---------------|----------|------|
| Number | Characteristics | Symbol | Min | Max | Min | Max | Min | Max | Min | Max | Min | Max | Unit |
| 1 | Cycle Time | t _{cyc} | 1.0 | 10 | 10 | 2.0 | 10 | 10 | 10 | 10 | 10 | 10 | μS |
| 2 | Pulse Width, E Low (See Note 6) | PWEL | 405 | 9500 | 430 | 1000 | 450 | 5000 | 430 | 5000 | 430 | 9500 | ns |
| 3 | Pulse Width, E High (See Note 6) | PWEH | 450 | 9500 | 450 | 1000 | 450 | 9500 | 450 | 9500 | 450 | 9500 | ns |
| 4 | Clock Rise and Fall Time (See Note 6) | t _r , tf | 1 | 100 | - | 25 | _ | 25 | - | 25 | _ | 25 | ns |
| 5 | Pulse Width, Q High | PWQH | - | _ | - | - | _ | - | 430 | 5000 | _ | _ | ns |
| 6 | Pulse Width, Q Low | PWQL | - | _ | - | _ | - | _ | 450 | 9500 | - | _ | ns |
| 7 | Delay Time, E to Q Rise* | DVA | - | _ | - | - | - | - | 200 | 250 | - | - | ns |
| 9 | Address Hold Time | tAH | 30 | _ | 20 | - | 20 | - | 20 | - | 10 | - | ns |
| 10 | Address Valid Time to Q Rise* | tAQ | - | _ | _ | _ | _ | - | 50 | _ | - | _ | ns |
| 11 | Address Delay from E Low (See Note 5) | tAD | - | 270 | _ | - | _ | - | _ | _ | _ | _ | ns |
| 12 | Non-Muxed Address Valid Time to E* (MPU) | tAV | _ | - | 200 | _ | 160 | - | _ | - | _ | - | ns |
| 13 | Addres Setup Time Before E (Periph) | tAS | - | _ | - | _ | _ | _ | _ | _ | 80 | _ | ns |
| 14 | Chip Select Setup Time Before E | tcs | _ | _ | _ | _ | | - | - | - | 80 | _ | ns |
| 15 | Chip Select Hold Time | tCH | _ | _ | _ | - | _ | - | _ | - | 10 | _ | ns |
| 16 | Non-Muxed Address Delay Time from AS | tAD | _ | _ | _ | | _ | - | _ | - | - | _ | ns |
| 17 | Read Data Setup Time | tDSR | 100 | _ | 80 | _ | 100 | - | 80 | - | _ | - | ns |
| 18 | Read Data Hold Time | TDHR | 10 | _ | 10 | - | 10 | - | 10 | - | 20 | 50 | ns |
| 19 | Write Data Delay Time (See Note 4) | tDDW | - | 225 | _ | 225 | _ | 225 | _ | _ | | _ | ns |
| 20 | Data Delay Time from Q | tDDQ | _ | _ | - | - | _ | - | - | 200 | - | - | ns |
| 21 | Write Data Hold Time (See Note 4) | tDHW | 10 | _ | 20 | - | 30 | _ | 30 | - | 10 | - | ns |
| 22 | Muxed Address Valid Time to E Rise* | tAVM | _ | _ | 200 | - | _ | - | _ | _ | _ | - | ns |
| 23 | Muxed Address Delay Time from AS | tADAS | _ | _ | _ | - | _ | - | _ | _ | _ | - | ns |
| 24 | Muxed Address Valid Time to AS Fall* | tASL | _ | _ | 60 | _ | _ | _ | _ | - | _ | - | ns |
| 25 | Muxed Address Hold Time | tAHL | _ | _ | 20 | - | _ | _ | _ | - | _ | <u> </u> | ns |
| 26 | Delay Time, AS to E Rise* | tASD | _ | - | 90 | _ | _ | _ | _ | _ | - | _ | ns |
| 27 | Pulse Width, AS High* | PWASH | _ | _ | 220 | _ | _ | _ | _ | - | _ | _ | ns |
| 28 | Delay Time, AS to E Rise* | tASED | _ | _ | 90 | _ | _ | _ | _ | _ | _ | _ | ns |
| 29 | Usable Access Time* (See Note 9) | tACC | 605 | - | 570 | _ | 605 | - | 695 | - | _ | T - | ns |
| 30 | Peripheral Output Data Delay Time | ^t DDR | _ | - | | _ | _ | - | _ | - | _ | 290 | ns |
| 31 | Peripheral Input Data Setup Time | tDSW | _ | _ | | = | | _ | _ | _ | 165 | _ | ns |
| 32 | Buffer Logic Delay Time Address, CS, R/W (See Note 10) | tBDA | 55 | _ | 120 | _ | 100 | - | 150 | - | _ | _ | ns |
| 33 | Buffer Delay Time, Read Data (See Note 11) | ^t BDR | 60 | _ | 80 | _ | 60 | - | 80 | _ | _ | - | ns |
| 34 | Buffer Delay Time, Write Data (See Note 12) | tBDW | 60 | _ | 60 | _ | 60 | _ | 365 | _ | _ | _ | ns |

^{*}At specified cycle time

TABLE 2-2. NMOS/HMOS GENERIC BUS TIMING CHARACTERISTICS FOR 1.5 MHz OPERATION

| ldent. | | | 68A00 | | 68A01 | | 68A02 | | 68A09 | | 68A21/ 68A59 | | |
|--------|---|---------------------------------|-------|------|-------|------|-------|------|-------|------|-----------------|------|------|
| Number | Characteristics | Symbol | Min | Max | Min | Max | Min | Max | Min | Max | Min | Max | Unit |
| 1 | Cycle Time | t _{cyc} | 0 667 | 10 | 0 667 | 2.0 | 0.667 | 10 | 0 667 | 10 | 0 667 | 10 | μS |
| 2 | Pulse Width, E Low (See Note 6) | PWEL | 230 | 9500 | 300 | 1000 | 280 | 5000 | 280 | 5000 | 280 | 9500 | ns |
| 3 | Pulse Width, E High (See Note 6) | PWEH | 280 | 9500 | 300 | 1000 | 280 | 9700 | 280 | 9700 | 280 | 9500 | |
| . 4 | Clock Rise and Fall Time (See Note 6) | t _r , t _f | - | 100 | _ | 25 | _ | 25 | _ | 25 | - | 25 | ns |
| 5 | Pulse Width, Q High | PWQH | _ | _ | _ | _ | _ | _ | 280 | 5000 | - | - | ns |
| 6 | Pulse Width, Q Low | PWQL | - | _ | _ | - | - | _ | 280 | 9700 | - | _ | ns |
| 7 | Delay Time, E to Q Rise* | DVA | _ | _ | - | _ | - | _ | 130 | 165 | _ | _ | ns |
| 9 | Address Hold Time | tAH | 30 | _ | 20 | | 20 | _ | 20 | _ | 10 | _ | ns |
| 10 | Address Valid Time to Q Rise* | tAQ | _ | _ | - | _ | _ | _ | 25 | _ | _ | _ | ns |
| 11 | Address Delay from E Low (See Note 5) | tAD | - | 180 | _ | _ | - | _ | _ | _ | _ | _ | ns |
| 12 | Non-Muxed Address Valid Time to E*(MPU) | tAV | - | _ | 115 | _ | 100 | _ | - | _ | _ | - | ns |
| 13 | Address Setup Time Before E (Periph) | tAS | - | - | - | _ | _ | | - | _ | 60 | _ | ns |
| 14 | Chip Select Setup Time Before E | tcs | _ | _ | _ | _ | _ | _ | _ | _ | 60 | _ | ns |
| 15 | Chip Select Hold Time | tCH | - | _ | - | _ | - | _ | - | _ | 10 | _ | ns |
| 16 | Non-Muxed Address Delay Time from AS | tAD | - | _ | - | _ | _ | _ | _ | _ | _ | _ | ns |
| 17 | Read Data Setup Time | tDSR | 60 | _ | 60 | _ | 70 | _ | 60 | _ | _ | _ | ns |
| 18 | Read Data Hold Time | TDHR | 10 | _ | 10 | | 10 | _ | 10 | _ | 20 | 50 | ns |
| 19 | Write Data Delay Time (See Note 4) | tDDW | _ | 200 | _ | 170 | - | 170 | _ | _ | _ | _ | ns |
| 20 | Data Delay Time from Q | tDDQ | - | _ | _ | _ | _ | _ | - | 140 | - | - | ns |
| 21 | Write Data Hold Time (See Note 4) | tDHW | 10 | _ | 20 | _ | 20 | - | 30 | _ | 10 | _ | ns |
| 22 | Muxed Address Valid Time to E Rise* | tAVM | _ | _ | 115 | _ | _ | _ | _ | - | _ | -, | ns |
| 23 | Muxed Address Delay Time from AS | tADAS | _ | _ | _ | _ | _ | _ | _ | _ | _ | _ | ns |
| 24 | Muxed Address Valid Time to AS Fall* | tASL | - | _ | 40 | _ | _ | _ | _ | _ | _ | _ | ns |
| 25 | Muxed Address Hold Time | tAHL | _ | _ | 20 | _ | - | _ | - | _ | _ | _ | ns |
| 26 | Delay Time, AS to E Rise* | tASD | _ | _ | 60 | | _ | _ | _ | | _ | _ | ns |
| 27 | Pulse Width, AS High* | PWASH | _ | _ | 140 | _ | - | _ | _ | _ | _ | _ | ns |
| 28 | Delay Time, AS to E Rise* | †ASED | _ | _ | 60 | _ | - | _ | _ | _ | _ | _ | ns |
| 29 | Usable Access Time* (See Note 9) | tACC | 400 | _ | 345 | | 310 | | 440 | | _ | _ | ns |
| 30 | Peripheral Output Data Delay Time | tDDR | _ | _ | _ | | _ | _ | _ | _ | _ | 180 | ns |
| 31 | Peripheral Input Data Setup Time | tDSW | _ | _ | _ | _ | _ | _ | - | | 80 | _ | ns |
| 32 | Buffer Logic Delay Time Address, CS, R/W (See Note 10) | tBDA | 40 | - | 55 | _ | 40 | - | 80 | _ | - | _ | ns |
| 33 | Buffer Delay Time, Read Data (See Note 11) | ^t BDR | 30 | - | 40 | _ | 20 | _ | 30 | _ | _ | _ | ns |
| 34 | Buffer Delay Time, Write Data (See Note 12) | tBDW | 0 | _ | 50 | _ | 30 | _ | 230 | _ | - | _ | ns |

^{*}At specified cycle time

TABLE 2-3. NMOS/HMOS GENERIC BUS TIMING CHARACTERISTICS FOR 2.0 MHz OPERATION

| ldent. | ent. | | 68B00 | | 68B01 | | 68B02 | | 68B09 | | 68B21/ 68B59 | | |
|--------|---|---------------------------------|-------|------|-------|------|-------|------|-------|------|-----------------|------|------|
| Number | Characteristics | Symbol | Min | Max | Min | Max | Min | Max | Min | Max | Min | Max | Unit |
| 1 | Cycle Time | t _{cyc} | 05 | 10 | 05 | 20 | 05 | 10 | 05 | 10 | 05 | 10 | μS |
| 2 | Pulse Width, E Low (See Note 6) | PWEL | 210 | 9500 | 210 | 1000 | 210 | 5000 | 210 | 5000 | 210 | 9700 | ns |
| 3 | Pulse Width, E High (See Note 6) | PWEH | 220 | 950 | 220 | 1000 | 220 | 9700 | 220 | 9700 | 220 | 9700 | ns |
| 4 | Clock Rise and Fall Time (See Note 6) | t _r , t _f | - | 100 | - | 20 | _ | 20 | _ | 20 | _ | 20 | ns |
| 5 | Pulse Width, Q High | PWQH | _ | _ | - | - | _ | _ | 210 | 5000 | - | - | ns |
| 6 | Pulse Width, Q Low | PWQL | _ | - | _ | _ | _ | - | 220 | 9700 | _ | _ | ns |
| 7 | Delay Time, E to Q Rise* | DVA | _ | _ | _ | - | _ | - | 80 | 125 | _ | _ | ns |
| 9 | Address Hold | ^t AH | 30 | _ | 10 | _ | 20 | _ | 20 | _ | 10 | _ | ns |
| 10 | Address Valid to Q Rise* | tAQ | _ | _ | _ | _ | _ | _ | 15 | _ | _ | _ | ns |
| 11 | Address Delay from E Low (See Note 5) | tAD | _ | 150 | _ | _ | _ | _ | _ | | _ | _ | ns |
| 12 | Non-Muxed Address Valid Time to E*(MPU) | tAV | _ | - | 70 | - | 50 | - | - | - | - | _ | ns |
| 13 | Address Setup Time Before E (Periph) | tAS | _ | _ | _ | _ | _ | _ | - | _ | 40 | _ | ns |
| 14 | Chip Select Setup Time Before E | tcs | _ | _ | _ | - | _ | _ | - | _ | 40 | _ | ns |
| 15 | Chip Select Hold Time | tCH | | - | _ | - | _ | _ | _ | _ | 10 | _ | ns |
| 16 | Non-Muxed Address Delay Time from AS | tAD | _ | - | _ | - | _ | - | _ | | - | - | ns |
| 17 | Read Data Setup Time | †DSR | 40 | _ | 40 | _ | 60 | _ | 40 | _ | _ | _ | ns |
| 18 | Read Data Hold Time | TDHR | 10 | _ | 10 | _ | 10 | - | 10 | _ | 20 | 50 | ns |
| 19 | Write Data Delay Time (See Note 4) | tDDW | _ | 160 | - | 120 | _ | 160 | - | _ | _ | _ | ns |
| 20 | Data Delay Time from Q | tDDQ | _ | _ | _ | - | _ | _ | - | 110. | _ | _ | ns |
| 21 | Write Data Hold Time (See Note 4) | tDHW | 10 | _ | 10 | _ | 20 | - | 30 | _ | 10 | _ | ns |
| 22 | Muxed Address Valid Time to E Rise* | tAVM | _ | _ | 80 | - | _ | _ | | _ | _ | _ | ns |
| 23 | Muxed Address Delay Time from AS | tADAS | _ | _ | _ | _ | _ | - | _ | _ | _ | | ns |
| 24 | Muxed Address Valid Time to AS Fall* | tASL | | - | 20 | - | _ | _ | - | _ | _ | _ | ns |
| 25 | Muxed Address Hold Time | ^t AHL | _ | _ | 10 | _ | _ | _ | _ | _ | _ | - | ns |
| 26 | Delay Time, AS to E Rise* | tASD | | _ | 45 | - | _ | - | - | _ | - | - | ns |
| 27 | Pulse Width, AS High* | PWASH | _ | _ | 110 | _ | _ | - | - | _ | _ | _ | ns |
| 28 | Delay Time, AS to E Rise* | tASED | _ | - | 45 | _ | _ | - | - | - | _ | _ | ns |
| 29 | Usable Access Time* (See Note 9) | tACC | 290 | - | 260 | - | 235 | _ | 330 | _ | - | - | ns |
| 30 | Peripheral Output Data Delay Time | †DDR | _ | _ | _ | - | - | - | _ | - | _ | 150 | ns |
| 31 | Peripheral Input Data Setup Time | tDSW | _ | _ | _ | _ | | - | _ | _ | 60 | _ | ns |
| 32 | Buffer Logic Delay Time Address, CS, R/W (See Note 10) | tBDA | 20 | - | 30 | - | 10 | - | 60 | - | - | - | ns |
| 33 | Buffer Delay Time, Read Data (See Note 11) | ^t BDR | 30 | _ | 30 | - | 15 | _ | 30 | _ | - | _ | ns |
| 34 | Buffer Delay Time, Write Data (See Note 12) | tBDW | 0 | - | 40 | - | 0 | | 160 | _ | _ | _ | ns |

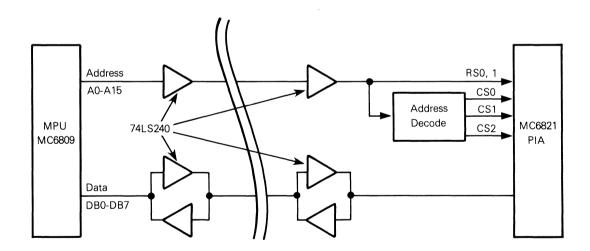
^{*}At specified cycle time

DIAGRAM/TABLE USE

As an example of the use of the timing diagram, consider the simple bus connections of an MC6809 executing a read bus cycle with a peripheral such as the MC6821 shown in Figure 2-2. The bus cycle, identified as #1 in Figure 2-1 begins when $\overline{\mathbb{E}}$ (#4) falls. The address output of the MC6809 is valid prior to the rising edge of Q by time #10.

The MC6821, as well as all other bus peripherals, requires that the register select inputs, derived from the address bus, be valid prior to the rising edge of \overline{E} by time #13. Similarly, address decoding for assertion of chip select(s) must be valid by time #14. The time available for address buffers and decoding logic is given by #32 and can be calculated from the equation in note 10.

FIGURE 2-2. SIMPLE BUS CONNECTION — EXAMPLE



At 1 MHz, the characteristics table for the MC6809 shows that 150 nanoseconds are available for the combination of the two 74LS240 address buffers in series with the address decoding logic shown in Figure 2-2. Standard LS-series buffers and gates may easily be used in such a case. At 2 MHz, the MC6809 provides 60 nanoseconds for address decoding logic. Characteristic #32 on the 2 MHz table also illustrates the dramatic improvement in technology attendant with the introduction of the MC6801 and MC6809 when compared with the MC6800 and MC6802. Schottky buffering is easily done in a 2 MHz system with either of these newer processors; the MC6809 even allows ample time for use of LS-series buffers at 2 MHz.

To continue with the example, data access occurs and output buffers are enabled within the MC6821 for the duration of \overline{E} (#3) when chip select is asserted. The peripheral output data will be valid by time #30. Propagation through any data bus buffer must be done quickly to ensure valid data to the MC6809 on or before the read data setup time (#17). This read buffer delay time is #33. The overall time between the existence of a valid address output from the microprocessor and the required input data valid (read setup time) is called the usable access time and is characteristic #29. This is the time provided by the microprocessor at any given bus rate, for address buffers, address decoders, ROM/RAM access time, and data bus buffers.

Table 2-4 shows a comparison of the different buffering arrangements possible in the various speed ranges for the MC6809 used in the example, and also for the MC6802 in a similar system. The buffers and gates listed are a representative sampling of those available. At 2 MHz, the MC68B02 does not provide any buffer delay time for a write operation. As a result, when operating at 2 MHz, the MC68B02 is limited to small unbuffered systems.

TABLE 2-4. BUFFER TIME EXAMPLES

| MPU | Available Address Buffer/Decode | Available Buffers and Decode | Margin (ns) | Da | | Available Buffers | Margin (ns) | |
|---------|---------------------------------------|--|----------------|----------|---------------|------------------------------|----------------|-----|
| | Time (ns) | (ns) | (110) | Buffer T | ime (ns) W | (ns) | R | W |
| MC6809 | 150 | MC6888/8T28 + 7440 (10+10+22) | 108 | 80 | 365 | MC6880/ 8T26 (14 + 14) | 52 | 337 |
| MC68A09 | 80 | MC6888/8T28 MC+74LS40 (10+10+24) | 36 | 30 | 230 | MC6880/ 8T26 (14 + 4) | 2 | 202 |
| MC68B09 | 60 | MC6888/8T28 MC+74LS40 (10+10+24) | 16 | 30 | 160 | MC6880/ 8T26 (14 + 14) | 2 | 132 |
| MC6802 | 100 | MC74LS240 MC+74LS40 (14+18+24) | 44 | 60 | 60 | MC74LS240 | 28 | 28 |
| MC68A02 | 40 | MC74LS240 MC+74LS40 (7+7+24) | 2 | 20 | 30 | 74S240 (7 + 7) | 6 | 16 |
| MC68B02 | 10 | 74S40 = (6) | 4 | 15 | 0 | _ | 15 | 0 |

In the case of multiplexed-bus parts such as the MC6801 and MC68120, additional consideration must be given to the multiplexed address output. The address is defined to be valid, in the case of the MC6801, prior to the fall of address strobe by time #24. (In the MC68120, address is valid after the rise of address strobe by time #23.) This is sufficient time to allow capture of the address by a transparent latch, such as the 74LS373. The propagation time required by this latch, and the location of address strobe within the E low time, reduces the time available for address decoding.

When this approach is used with processors that include an on-chip oscillator (e.g., MC6801, MC6802, MC6809), specify address valid by xx (#10, #12, or #24) nanoseconds before \overline{E} or \overline{Q} rise or \overline{AS} fall.

When this approach is used with processors that require external \overline{E} or \overline{AS} input (e.g., MC6809E or MC68120), specify address valid by xx (#11 or #23) nanoseconds after \overline{E} fall or \overline{AS} rise.

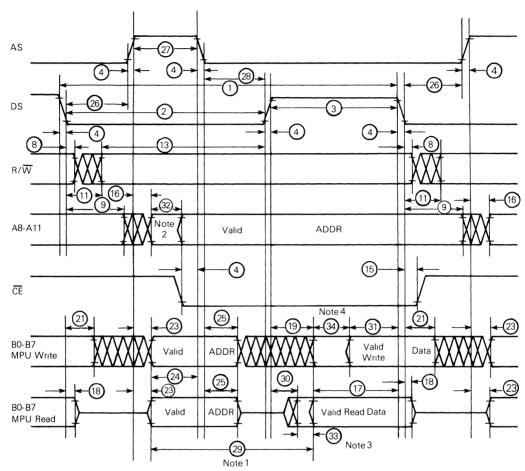
Do not consider the address output of any microprocessor valid until all appropriate parameters (#11, #12, #16, #22, or #23) have been considered.

THE CMOS GENERIC BUS

The timing diagrams shown in Figure 2-3 and the timing characteristics given in Table 2-5 may be considered as a special case of the generic bus. This information pertains to Motorola's rapidly expanding family of CMOS microprocessors and peripherals, beginning with the MC146805E2 and the MC146818.

The identification numbers shown are consistent with those in Figure 2-1 for the NMOS/HMOS generic bus. The waveforms have been drawn to indicate the input and output relationships of the MC146805E2 and MC146818. The characteristic table shows, in addition to the MC146805E2 and the MC146818, timing characteristics for Motorola's CMOS ROM, the MCM65516, available in two speed ranges. Both the MCM65516 and the MC146818 contain the MOTEL circuit, allowing direct application to both the Motorola generic bus and the competitive 8085-type bus. Always refer to the latest data sheet or other technical documentation for up-to-date characteristics for all Motorola microcomponents.

FIGURE 2-3, CMOS GENERIC BUS TIMING DIAGRAM



NOTES:

- 1. Available access time:
 - mux = 24 (MPU) + 28 + 3 17non-mux = 27 + 28 + 3 - 17 - 16
- 2. Buffer delay (address):

mux = 24 (MPU) -24 (peripheral) non-mux = 27 - 16 - 24 (peripheral)

- 3. Buffer delay (data read) = 3 30 17
- 4. Buffer delay (data write) = 3 19 31
- 5. V_{Low} = 0.5 V, V_{High} = 2.0 V for V_{DD} = 3 V; V_{Low} = 0.8 V, V_{High} = V_{DD} 2.0 V for V_{DD} = 5 V \pm 10%.

TABLE 2-5. CMOS GENERIC BUS TIMING CHARACTERISTICS **FOR 1.0 MHz OPERATION**

| Ident. | Characteristic | Symbol | MC146 | 805E2 | MC14 | 16818 | MC65 | 516-43 | MC65 | 516-55 | Unit |
|--------|---|---------------------------------|-------|-------|------|-------|------|--------|------|----------|-------|
| Number | Characteristic | Syllibol | Min | Max | Min | Max | Min | Max | Min | Max | Ollit |
| 1 | Bus Cycle Time | tcyc | 1000 | DC | 953 | DC | 580 | DC | 725 | _ | ns |
| 2 | Pulse Width, DS Low | PWDSL | 560 | _ | 300 | | _ | - | _ | | ns |
| 3 | Pulse Width, DS High | PWDSH | 375 | _ | 325 | _ | | - | _ | - | ns |
| 4 | Clock Rise and Fall Time | t _r , t _f | _ | 30 | _ | 30 | | _ | _ | | ns |
| 8 | R/W Hold Time | tRWH | 10 | _ | _ | _ | | _ | | | ns |
| 9 | Non-Muxed Address Hold Time | ^t AH | 100 | _ | _ | _ | 50** | _ | 80 | | ns |
| 11 | R/\overline{W} Delay Time from DS | ^t RWD | _ | 300 | - | _ | _ | _ | _ | | ns |
| 13 | R/W Setup Time to DS | tRWS | _ | 195 | _ | _ | _ | - | _ | _ | ns |
| 14 | Chip Enable Setup Time to AS Fall | tCES | _ | _ | 55 | - | 50 | - | 50 | _ | ns |
| 15 | Chip Enable Hold Time | tCEH | 1 | - | 0 | - | 50** | - | 80 | ı | ns |
| 16 | Non-Muxed Address Delay Time from AS | tAD | 0 | 100 | - | | | | | | ns |
| 17 | Read Data Setup Time | tDSR | 115 | | _ | - | - | 1 | _ | | ns |
| 18 | Read Data Hold Time | tDHR | 0 | 140 | 10 | 100 | 0 | 160 | 0 | 160 | ns |
| 19 | Write Data Delay Time | tDDW | | 120 | | | - | ١ | _ | _ | ns |
| 21 | Write Data Hold Time | tDHW | 55 | _ | 0 | - | - | 1 | _ | _ | ns |
| 23 | Muxed Address Delay Time from AS | tADAS | 0 | 120 | - | - | _ | _ | - | _ | ns |
| 24 | Muxed Address Valid Time to AS Fall * | tASL | 55 | _ | 55 | _ | 50 | _ | 50 | | ms |
| 25 | Muxed Address Hold Time | †AHL | 60 | 180 | 20 | _ | 50 | _ | 80 | _ | ns |
| 26 | Delay Time, DS to AS Rise * | tDSD | 160 | _ | 50 | _ | 50 | _ | 50 | _ | ns |
| 27 | Pulse Width, AS High* | PWASH | 175 | - | 100 | - | 150 | _ | 175 | _ | ns |
| 28 | Delay Time, AS to DS Rise * | †ASDSD | 160 | | 90 | - | 100 | _ | 160 | <u> </u> | ns |
| 29 | Usable Access Time *(See Note 1) | tACC | 475 | _ | _ | _ | _ | 430 | _ | 550 | ns |
| 30 | Peripheral Output Data Delay Time | tDDR | 260 | _ | 20 | 240 | 175 | _ | 200 | | ns |
| 31 | Peripheral Input Data Setup Time | tDSW | _ | - | 220 | - | | _ | | _ | ns |
| 32 | Buffer Logic Delay Time Address, CS, R/W (See Note 2) | tBDA | - | - | _ | - | 5 | _ | _ | | ns |
| 33 | Buffer Delay Time, Read Data (See Note 3) | tBDR | 20 | | | _ | | _ | | _ | ns |
| 34 | Buffer Delay Time, Write Data (See Note 4) | tBDW | 35 | _ | _ | - | _ | _ | - | _ | ns |

^{*}At specified cycle time
**Hold times for MCM65516 are from AS fall and are easily met by MC146805E2

Reliability 3



RELIABILITY REPORT NUMBER 8110

THE MC6800 MICROPROCESSOR FAMILY

MARCH 1981

PREPARED RY-

DANDAS TANG

MICROPROCESSOR

RELIABILITY ENGINEERING

APPROVED BY:

ED DASSE, MANAGER

MOS RELIABILITY ENGINEERING

Motorola: the Reliability Name In Semiconductors

Test results contained herein are for information only. This report does not alter Motorola's standard warranty or product specifications.

Introduction

Motorola conducts extensive reliability testing to evaluate new processes and materials, and to monitor performance levels. The test methods used to evaluate the MC6800 family of NMOS LSI microprocessors and peripheral device types are described in this report. Data reduction techniques and prediction models are included, in addition to a comprehensive summary of life and environmental test data. The life test data base consists of results obtained on 8,761 devices representing twenty different types, including two recently introduced circuits. Sixty percent of the life test data and all of the environmental test results constitute new information not available in previous reports. After five million device-hours of 125°C testing, an overall 70°C failure rate of 0.032%/1000 hours was observed. This performance is particularly impressive when the complexity and density of microprocessors are considered.

Also of significance is the exceptional environmental performance demonstrated by the MC68XX plastic package. The low operating potentials and moderate power levels of NMOS microprocessors result in excellent moisture resistance verified by temperature-humidity-bias testing. The integrity of die and wire bonds, as well as the matching of expansion coefficients, are examined in the temperature cycle test where 40-pin packages were shown to perform as well as 14-pin devices.

This report, describing MC68XX reliability, is the most comprehensive to date. The 1980 reliability data bases are expanded and revised with new test information which improves the accuracy of the reliability predictions. In addition, the report includes application data useful in system design and qualification of MC68XX devices. The excellent reliability of the MC6800 family reflects the high priority given to reliability and quality standards by Motorola as an integral part of its corporate objectives.

Accelerated Life Testing

Accelerated operating life testing is used to simulate continuous system operation while decreasing the time required to observe long-term effects. The test is typically conducted at an ambient temperature of 125°C for 1008 hours with electrical measurements performed at the 0, 24, 168, 504, and 1008 hour points. The value of the resultant failure rate is dependent on many variables, the most important being:

- 1. Temperature
- 2. Voltage
- 3. Biasing Technique
- 4. Failure Criteria
- 5. Acceleration Factor
- 6. Confidence Limit

Since the manipulation of these can produce a wide range of results, it is imperative that the customer have an adequate understanding of how these variables can contribute to the reported failure rate. This section provides a brief narrative describing the test conditions and results while more details are found in the appendices.

Methods

The life test circuits were designed to simulate system operation by dynamically exercising the internal circuitry of each device type. Dynamic biasing is preferred to static biasing of LSI devices since the continual switching of internal nodes more closely simulates the application. Appendix B, **Accelerated Life Test Techniques**, describes the biasing arrangements used in life testing.

Electrical measurements were obtained with Fairchild Sentry Systems and test programs employing exhaustive functional routines under worst-case supply and clock conditions. Pass/fail criteria are established for each circuit type based on data sheet limits of AC, DC, and timing parameters. Devices which do not meet a test criterion are segregated by failure mode, data logged and analyzed, when appropriate, to determine specific failure mechanisms.

Equivalent device-hours and individual MC68XX failure rates are based on junction temperatures measured on test samples. A significant characteristic of NMOS devices is a decreasing power versus temperature relationship; this characteristic improves device reliability in severe environments since the rate of junction temperature rise decreases with increasing ambient temperature. The calculation of acceleration factors and failure rates using junctions rather than ambient temperature is a more conservative approach and is employed in all MOS reliability data. The Chi-Square distribution was used at the 60% confidence level to determine the failure rate values shown in this report (Tables 1 and 2, Figure C2). Appendix B illustrates in detail the steps involved in this calculation.

Results

Table 1 summarizes the life test results obtained by Motorola on devices sourced from mask sets used in production during 1980. The system failure rate reflects the expected field performance due to catastrophic failures while the total failure rate also includes devices demonstrating parametric degradation which is not likely to impair system performance.

The life test results presented in Table 2 include over three hundred million device-hours and an overall 70°C system failure rate of 0.018%/1000 hours (MTBF = 5.6×106 hours) measured on standard product without preconditioning. Plastic and ceramic devices demonstrated failure rates of 0.022%/1000 hours and 0.012%/1000 hours, respectively. For a detailed description of failure modes observed during accelerated life testing refer to Appendix D, **Electrical Testing and Failure Characteristics**.

TABLE 1 SUMMARY OF 1980 LIFE TEST DATA

| Device Grouping | Wafer Lots | Test Devices | 70°C Equivalent Device-Hours | 70°C System Failure Rate (%/1000 Hrs.) | 70°C Total Failure Rate (%/1000 Hrs.) | |
|--------------------|---------------|-----------------|---------------------------------|--|---|--|
| Microprocessors | 92 | 4,462 | 120 1 × 106 | 0 027 | 0 039 | |
| Peripheral Devices | 59 | 2,962 | 156 6×10 ⁶ | 0 018 | 0 033 | |
| RAMS | 5 | 353 | 17 9×106 | 0 017 | 0 040 | |
| ROMS | 23 | 984 | 59 7 × 10 ⁶ | 0 009 | 0 014 | |
| Total | 179 | 8,761 | 354 3 × 106 | 0 018 | 0 032 | |

TABLE 2 MC6800 FAMILY RELIABILITY

| Device Type | MOS Technology | Wafer Lots | Test Devices | Failures | | Device- Equivalent | | Average Junction Temperature at | | 70° System Failure Rate | |
|------------------|-------------------|---------------|-----------------|--------------|-------|--------------------|------------------------|---------------------------------------|---------|-------------------------------|-----------------|
| | , | | | Catastrophic | Total | Hours | Device-Hours | T _A = | /0°C | %/ 1000 Hrs. | %/ 1000 Hrs. |
| Microprocessors | | | | | | | | Ceramic | riastic | 1000 HIS. | 1000 Hrs. |
| MC6800 | N | 25 | 1.069 | 13 | 18 | 895.628 | 54 4×106 | 83 | 92 | 0 025 | 0 034 |
| MC6802/08 | N | 42 | 1,665 | 15 | 24 | 1.576.864 | 46 0 × 106 | 91 | 116 | 0 025 | 0.051 |
| MC6805 | H | 19 | 1,000 | 2 | 24 | 234,672 | 10 8 × 10 ⁶ | 88 | 102 | 0 035 | 0 028 |
| MC6809 | H | 6 | 229 | 2 | 3 | 168,359 | 8 9× 10 ⁶ | 88 | 102 | 0 028 | 0 028 |
| Peripheral Logic | | | | | | | | | | | |
| MC6821 | N | 19 | 1,113 | 6 | 13 | 1.067.069 | 59 2 × 106 | 79 | 92 | 0.012 | 0 023 |
| MC6840 | N | 4 | 159 | ō | 0 | 159.632 | 10 8 × 106 | 80 | 87 | 0 008 | 0 008 |
| MC6845 | N | 3 | 135 | 0 | 0 | 90.720 | 5 0 × 10 ⁶ | 89 | 105 | 0 018 | 0 018 |
| MC6846 | N | 5 | 294 | 5 | 6 | 356,688 | 10 8 × 106 | 89 | 109 | 0 057 | 0 066 |
| MC6847 | N | 3 | 133 | 2 | 6 | 110,040 | 5 4 × 106 | 83 | 94 | 0 052 | 0 120 |
| MC6850 | N | 11 | 477 | 2 | 3 | 478,223 | 27 1 × 10 ⁶ | 81 | 92 | 0 011 | 0 015 |
| MC6852 | N | 3 | 117 | 1 | 7 | 129,360 | 8 11 × 10 ⁶ | 83 | 91 | 0 025 | 0 100 |
| MC6854 | N | 4 | 207 | 1 | 3 | 205,176 | 9 1 × 10 ⁶ | 89 | 101 | 0 022 | 0 045 |
| MC6860 | N | 2 | 76 | 4 | 4 | 72,984 | 57×106 | 79 | 81 | 0 091 | 0 091 |
| MC6862 | N | 3 | 170 | 5 | 7 | 159,740 | 12 2×106 | 78 | 84 | 0 051 | 0 068 |
| MC68488 | N | 2 | 81 | 1 | 2 | 78,336 | 3 2×10 ⁶ | 85 | 98 | 0 061 | 0 095 |
| RAM | | | | | | | | | | | |
| MCM6810 | N | 5 | 353 | 2 | 6 | 384,912 | 17 9× 10 ⁶ | 83 | 92 | 0 017 | 0 040 |
| ROMs | | | | | | | | | | | |
| MCM6830/308 | N | 10 | 361 | 2 | 4 | 287,981 | 21 0×10 ⁶ | 81 | 88 | 0 014 | 0 025 |
| MCM68316 | N | 6 | 218 | 0 | 0 | 133,728 | 5 7×106 | 86 | 96 | 0 016 | 0 016 |
| MCM68332 | N | 4 | 274 | 1 | 2 | 156,984 | 10 8 × 106 | 78 | 83 | 0 019 | 0 029 |
| MCM68364 | н | 3 | 131 | 1 | 1 | 264,096 | 22 2×106 | 75 | 78 | 0 009 | 0 009 |

Plastic Package Environmental Performance

Molded dual-in-line packages are an attractive, low-cost alternative to hermetically-sealed systems. Plastic is lighter, less expensive, and much more resistant to physical damage than a ceramic device. However, there are four primary concerns: contamination, moisture resistance (corrosion), wire bond integrity, and thermal performance. The accelerated life test described in the previous section produced no significant difference in plastic and ceramic performance, thereby indicating the absence of a plastic contamination mechanism. This section addresses the moisture resistance and wire bond integrity of the product. Refer to Appendix A for additional descriptions of the packaging systems and their thermal characteristics.

Temperature-Humidity-Bias Testing

The Temperature-Humidity-Bias (THB) test is used to evaluate the moisture resistance of plastic devices by employing severe conditions (85°C, 85% RH, 5 V) to accelerate corrosion of the metallization. The biasing circuits used in THB testing create static electric fields between adjacent metal areas, thereby increasing the incidence of electrolytic cells while minimizing power dissipation.

Each THB sample is sourced from a separate wafer lot and tested for a period of 1008 hours. Electrical measurements are performed at the 0, 168, 336, 504, and 1008 hour points using Sentry test systems with complete parametric and functional test programs. The pass/fail criteria used for life test samples are also employed with THB samples. A worst-case analysis is presented since all electrical failures are considered instead of only those associated with the corrosion mechanisms.

TABLE 3
TEMPERATURE-HUMIDITY-BIAS (85°C/85% R.H./+5 V) TEST RESULTS

| | Cumulative Test Time (Hr.) | | | | | | | |
|------------------------|----------------------------|------|------|------|--|--|--|--|
| | 168 | 336 | 504 | 1008 | | | | |
| Test Devices | 576 | 338 | 569 | 561 | | | | |
| Failures | 2 | 1 | 4 | 3 | | | | |
| Percent Defective | 0 35 | 0 30 | 0 70 | 0 53 | | | | |
| Cumulative % Defective | 0 35 | 0 65 | 1 35 | 1 88 | | | | |

The data presented in Table 3 is based on testing of 576 devices in which ten failures were observed. A Weibull plot (Figure 1) shows a comparison of the performance measured in 1979 and 1980, respectively. This excellent performance is attributed to two factors. First, corrosion takes place because an electrolytic cell is present which is field-strength dependent and, therefore, has a lower reaction rate with 5-volt bias than with higher supply levels. Secondly, the cell requires an electrolyte which is created by the ingression of moisture reacting with minute quantities of ionic material. The power dissipation of these devices increases the temperature of the die surface, helping to drive off moisture which prevents cell formation.

1008

Test Time In Hours

10K

FIGURE 1 — WEIBULL PLOT OF TEMPERATURE-HUMIDITY-BIAS TEST RESULTS

Temperature Cycle Testing

0.01

168

336 504

The integrity of wires and die bonds in plastic packages can be accurately evaluated through temperature cycle testing. MIL-STD-883B, Method 1010.4, Condition C is employed to permit easy comparison with other sources of data. Condition C dictates a cycle from $-65\,^{\circ}\text{C}$ to $+150\,^{\circ}\text{C}$ with a fifteen minute dwell time. This is a particularly severe range which induces stress on the wires and bonds due to differences in the thermal coefficients of expansion between the wire, lead frame, and encapsulant. Air-to-air cycling has been shown to be more severe than liquid-to-liquid thermal shock testing of this mechanism. This surprising difference is probably due to the longer dwell time for temperature cycle and the fact that the internal movement involves a relatively slow relaxation of the package components. The predominant failure mechanism is wire breakage above the ball bond where the heat and stress of the bonding process reduce the strength of the wire. End point continuity testing at 125 °C is used to detect potential intermittents.

TABLE 4
TEMPERATURE-CYCLE TEST RESULTS

| | Cumulative Test Cycles | | | | | | | | |
|------------------------|------------------------|------|------|------|------|--|--|--|--|
| | 100 | 250 | 500 | 750 | 1000 | | | | |
| Test Devices | 2250 | 2218 | 2193 | 2086 | 2050 | | | | |
| Failures | 2 | 7 | 8 | 5 | 8 | | | | |
| Percent Defective | 0 09 | 0 32 | 0 36 | 0 24 | 0 39 | | | | |
| Cumulative % Defective | 0 09 | 0 41 | 0 77 | 1 01 | 1 40 | | | | |

The temperature cycle test results presented in Table 4 reflect the effort directed toward process control and its achievement of a consistently reliable bonding system. Over two thousand plastic devices from thirty separate assembly lots were tested to 1000 cycles resulting in thirty failures. Of these, twelve were caused by broken bond wires, while the remainder involved nonmechanical problems.

Handling Precautions

All MOS and many bipolar technologies require precautions against high static voltages. It is important that conductive or antistatic materials be employed at all work stations. Operators should use wrist straps and work surfaces should be conductive. Attention should be paid to the completed boards as well as the components since high-impedance circuit nodes are readily accessible. Although most static damages cause failures immediately, a small portion may continue to function and fail in the field.

A second type of precaution involves the CERDIP package. Since this device employs a glass seal, a high stress on the leads can cause hermeticity failure which will eventually result in aluminum corrosion on the die. To avoid this, the leads should never be flexed above the seating plane. All insertion tools or automated equipment should contact the lead at its narrowest dimension allowing it to bend without affecting the wide portion above the seating plane.

Glass Seal

CERDIP Package
Insertion Tool

55 Mil Minimum Width

Minimum Width

FIGURE 2 — CERDIP INSERTION PRECAUTIONS

Quality And Testing

A complete Reliability and Quality Assurance System is in place to monitor and control the performance of Motorola MOS products. Incoming Quality Control inspects starting wafers, masks, chemicals, package piece parts, and molding compounds. Process Engineering and In-Process Quality Control perform step-by-step inspections in the wafer area to check the oxidation, diffusion, photoresist, and metallization operations. Final visual, class probe and capacitance voltage plot screens complete the wafer area inspections. In the assembly area, In-Process Quality Control performs monitor (random sample) and gate (all lots) inspections at each of the major process steps. The Outgoing Quality Control group continues this philosophy in the final test area by gating electrical, mechanical, visual, and clerical requirements. Refer to Appendix A for descriptions of the process flow for ceramic and plastic MC68XX devices.

The Reliability Engineering group performs qualifications of new designs and process changes prior to introduction. Many short term tests are performed on an ongoing basis to monitor the trends of all process lines; these provide rapid feedback to correct negative perturbations before they can affect device performance. Supporting the efforts of these groups are the Standards Laboratory, the Metrology Laboratory, the Chemical Laboratory, and a sophisticated Product Analysis Laboratory.

Reliability And Quality Assurance Process Reliability Quality Quality Analytical Development Assurance Laboratories Engineering Control Reliability Burn-In and Incoming Quality Chemical Laboratory Logic and Special New Processes Control Environmental Functions Laboratory Lot Processing Wafer Fabrication Product Analysis New Technologies Memory In-Process Laboratory Quality Control Microprocessors New Equipment Outgoing Quality Assembly In-Process Control Quality Control Metrology Quality Control Engineering Laboratory Specifications Standards Department Laboratory

FIGURE 3 — RELIABILITY AND QUALITY ASSURANCE ORGANIZATION

Conclusion

The reliability data examined in this report represents the cumulative results of recently completed test programs. The specific tests were chosen to be those most representative of MC68XX field performance. Failure rate estimates were based on the outcome of tests and data analysis which are widely accepted and conservative. The level of performance predicted by this data is among the best available in the industry and far exceeds the requirements of most applications. Comparison to previous reports verifies a history of continuous improvement which has made Motorola MOS LSI the optimum choice for system reliability.

Copies of this and other reliability reports may be obtained from your local Motorola representative. For additional information, contact Reliability (512)928-6640 or Marketing (512)928-6800 organizations or write to:

Reliability Engineering Motorola Inc. 3501 Ed Bluestein Blvd. Austin. Texas 78721

APPENDIX A A COMPARISON OF PACKAGING SYSTEMS

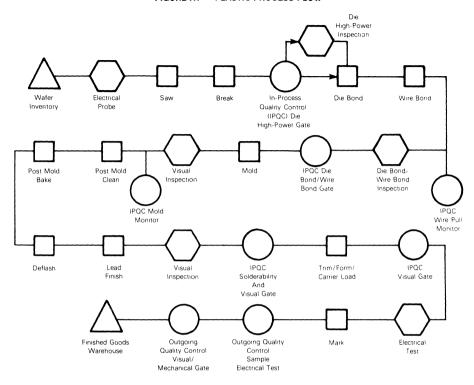
The MC6800 family of microcomputers and NMOS peripheral device types are produced in plastic, CERDIP and sidebraze packages. The ceramic packages are hermetically sealed to protect the integrated circuit from environmental factors and permit operation over extreme temperature ranges. Although plastic devices are nonhermetic, modern epoxies exhibit extremely high moisture resistance and long lifetimes may therefore be expected from these integrated circuits in typical environments. Extensive reliability testing has been performed to evaluate the three package types as specified in Report 7639-2, Package Qualification Program Plan.

Plastic

Encapsulated integrated circuits incorporate the simplest processing and package construction of the various systems available. The die is attached to a lead frame, wire bonded and encapsulated by a filled resin. The lead frame may be copper, or alloy 42, and the die attach may be epoxy, gold silicon eutectic, or a variety of eutectic forming metal foils. Wire bonding may be thermocompression or thermosonic, but the wire is always gold. This system has evolved from early industry experiments with aluminum ultrasonic wire bonding which experienced high rates of opens and intermittents. The encapsulant is the most critical component of the system since it controls contamination, moisture resistance, and stress effects. Epoxy novolacs have become the standard molding compound since they combine excellent characteristics in all these areas. Silicones are very susceptible to moisture and contamination ingression, and die coats have induced disasterous stresses on the wire bonds.

The plastic package is, by far, the most resistant to physical damage since the die is completely encapsulated and cavity hermeticity is not a concern. Since the package is light in weight and the plastic is less brittle than ceramic, chipping and cosmetic damage are not problems. The lead frame and plating are equivalent to CERDIP, and modern epoxies pose no danger from contamination. Only two areas have yielded poorer performance: moisture resistance and thermal resistance. Moisture resistance is a function of encapsulant porosity and adhesion to the lead frame. Vendors of molding compounds are constantly improving these parameters; but, even in their present state, the low voltage and moderate power dissipation of microprocessor devices provide excellent performance which is rarely distinguishable from hermetic performance (refer to Figure 1). Thermal resistance has been improved dramatically through the introduction of copper lead frames and heat spreaders with values even lower than those of currently available ceramic packages.

FIGURE A1 - PLASTIC PROCESS FLOW



Hermetic

Two package styles are commonly used for dual-in-line hermetic applications. The CERDIP package is composed of two layers of black alumina with the seal formed between these by a glass frit layer. The kovar or alloy 42 lead frame is embedded in the glass and has aluminum deposited on the internal lead tips to provide a compatible surface for ultrasonic aluminum wire bonding. The lead frame is formed into the dual-in-line configuration prior to assembly to prevent unnecessary stress of the glass seal. Both the lid and the base alumina have recesses to provide a cavity and the base recess is usually coated with a gold or paladium silver frit for die bonding. Glass die bonding is occasionally used for small die but LSI devices require a eutectic bond to minimize the thermal expansion mismatch. Tin plating is applied to the leads subsequent to the sealing operation.

The solder seal package is composed of three layers of alumina which are screened with a refractory metal such as tungsten or moly manganese and fired together to form the package body with a cavity for the die. The refractory metal is then plated and kovar or alloy 42 lead frames are brazed to the bottom, sides or top of the package, depending on the vendor. The advantage of the sidebraze version is accurate lead alignment without the need for forming. The final piece part operation is plating which may be gold or tin with a selective gold plate in the cavity. Versions are also available, without a metal seal ring, for a frit seal ceramic lid similar to the CERDIP package. Although epoxy die bonding is feasible in this package due to the lower sealing temperature, most manufacturers employ a eutectic bond. Both aluminum ultrasonic wire bonding and gold thermocompression bonding are used.

FIGURE A2 - HERMETIC PROCESS FLOW

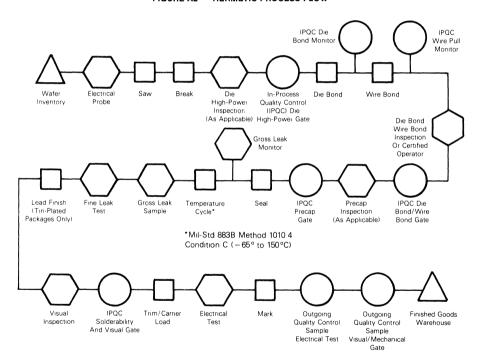


TABLE A1 A COMPARISON OF PACKAGING MATERIALS AND PROPERTIES

| | Sidebraze | CERDIP | Plastic | |
|--|----------------------|--------------------------|---|--|
| Package Body | Alumina | Alumina | Epoxy Novolac | |
| External Leads | Brazed Kovar | Formed Alloy 42 | Formed Alloy 42/Copper | |
| Internal Leads | Gold-Plated Tungsten | Aluminum-Coated Alloy 42 | Gold-Plated Alloy 42/ Silver-Plated Copper | |
| External Lead Plating | Tin | Tin | Tin/Solder | |
| Seal | Solder | Glass | N A | |
| Die Bond | Eutectic | Eutectic | Eutectic/Epoxy | |
| Wire Bond | Ultrasonic | Ultrasonic | Thermo-Compression | |
| Wire | Aluminum-Silicon | Aluminum-Silicon | Gold | |
| Typical Thermal Resistance ($	heta$ JA) Leads | | | | |
| 24 | 52 | 52 | 120/80 | |
| 28 | 50 | 51 | 112/74 | |
| 40 | 40 | 50 | 95/42 | |
| Marking Suffix | Marking Suffix L | | Р | |

Some tradeoffs exist in the performance characteristics of the two hermetic packages as they are offered by Motorola. Both are ceramic, hermetic, employ a eutectic die bond, use ultrasonic aluminum wire bonding, and have tin plating. The thermal resistance of the packages is very similar, with the sidebraze having a slight advantage. Both packages perform well on the standard thermal and mechanical environmental tests, but each is susceptible to handling damage. Loose shipping rail packaging or high velocity impacts during testing can chip the sidebraze package and sever the interlayer metallization. This type of handling will not affect the 10 mil thick lead frame of the CERDIP package, but hermeticity failures can occur. The CERDIP package is slightly thicker and heavier, but no conductive surfaces are exposed so the shorting potential in dense packaging is reduced. Another difference is the fact that CERDIP devices employ an all aluminum wire bonding system and are immune to the intermetallic problems of multimetal systems. Extensive testing of 24-, 28-, and 40-lead CERDIP and sidebraze devices has indicated no significant difference in reliability.

APPENDIX B ACCELERATED LIFE TEST TECHNIQUES

The test results reported in previous sections were obtained through the use of procedures employed throughout the semiconductor industry. This section details those methods as applied by Motorola to perform accelerated tests and the subsequent analysis.

TEST TECHNIQUES

Accelerated Life Testing is used to simulate continuous system operation while decreasing the time required to observe long-term effects. This test method is designed to detect latent defects in the integrated circuit and some types of packaging defects which occur in accordance with the relatively well-defined models described in this section. The operating parameters of temperature, time, and voltage are controlled during the test, while moisture and other atmospheric constituents are assumed to be insignificant.

The accelerated life test is widely accepted as a qualification test method for integrated circuits and is consistent with Method 1005.3, Steady State Life, Conditions D and F. contained in MIL-STD-883B. Each device type uses a distinct driver circuit capable of dynamically exercising internal nodes of the integrated circuit. Most of the waveforms are derivatives of a common clock signal and are therefore easily implemented with a minimum of circuitry. The VDD supply levels are regulated at the nominal rated value of the devices. It is also important that supply lines be adequately decoupled and be of sufficient cross-sectional area to prevent excessive voltage drop. Signal-carrying metal traces on oven trays are limited to the shortest possible physical distances to prevent undesired reflections and cross talk between lines. In order to insure that test devices are properly exercised during the test, mid-range clock frequencies are chosen for each device type based on data sheet limits. Increasing clock speed does not have a significant effect on the power dissipation of MC68XX devices with unloaded outputs and is not, therefore, an important factor in determining reliability. These circuits permit high density testing and avoid the potential for accidental overstress of the parallel test devices. Some pins are electrically isolated from device to device, since parallel connections may prevent device functions or lead to overstress; this is accomplished by removing designated socket pins from the life-test oven board.

The ambient test temperature is typically 125°C, although any value above the maximum system temperature will provide acceleration. Junction temperatures become a limiting factor near 180°C for laminated ceramic devices and 150°C for plastic devices. At these temperatures gold-aluminum intermetallics begin to form in the ceramic packages and plastic encapsulants start to decompose. Junction temperature for CER-DIP devices is limited only by circuit leakages which affect all package types above 150°C. A supply current measurement during the test will reveal the maximum permissible ambient temperature. Since supply currents will decrease with temperature at an average rate of -0.25%/°C, extrapolations are possible if a reference point is obtained initially. Test duration is 1008 hours, and electrical measurements are performed at 0, 168, 504, and 1008 hours. More frequent measurements are performed to observe infant mortality characteristics, but frequent handling increases the likelihood of physical or electrical damage to the sample.

ANALYSIS OF RESULTS

Upon completion of the test, failed devices are examined to characterize failure modes and determine whether a pattern exists which would justify a physical analysis of the failure mechanism. Failure rates are expressed in failures-per-hour and are calculated using the Chi-Square distribution in the equation:

$$\lambda \leq \frac{\chi^2(\alpha, d.f.)}{2t}$$

Where: (1)

λ = Failure Rate

 χ^2 = Chi-Square Function

 $\alpha = \frac{100 - \text{Confidence Level}}{100}$

d.f. = Degrees of Freedom = 2r + 2

r = Numbers of Rejects

t = Device-hours

If a test has been conducted at the ambient temperature of the system, then device-hours can be calculated directly and substituted into Equation 1. Since it is not practical to observe long-term effects at system temperatures, the test is accelerated and therefore requires a basis for equating device-hours at the test temperature to device-hours at the temperature of operation. Acceleration factors express this ratio and are derived from the Arrhenius relationship in Equation 2. One electron-volt is used as the activation energy value based on Motorola's experience and data from other industry sources.

$$F_{a} = \exp \left[(\theta/K) \cdot \left(\frac{1}{T_{0}} - \frac{1}{T_{t}} \right) \right]$$
 (2)

Where:

 $F_a = Acceleration Factor$

 $\theta = Activation Energy in eV$

 $K = Boltzman's Constant, 8.62 \times 10 - 5 eV/°K$

To = Operating Temperature in °K

Tt = Test Temperature in °K

Parameters T_t and T_0 of Equation 2 are the average junction temperatures present during the test and in system operation, respectively. Motorola uses junction rather than ambient temperatures since they produce more conservative and representative acceleration factors. Junction temperatures can be derived from power dissipation measurements and Equation 3. The thermal resistance (θ_{JA}) values of MC68XX devices are given in Appendix A and may be measured using the procedure outlined in Reliability Report 7843, **Thermal Resistance Measurement Method for Microcomponent Devices.** These values were obtained under "still-air" conditions and are, therefore, slightly pessimistic for most systems. MIL-STD-883B Method 1005.3 provides a derating curve for thermal resistance based on linear air movement.

$$T_{J} = T_{A} + P_{D}\theta_{JA}$$

(3)

T.J = Junction Temperature in °C

Where:

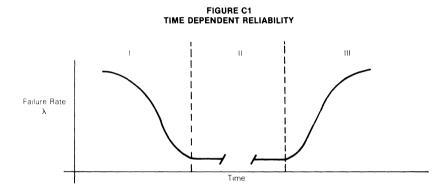
TA = Ambient Temperature in °C

PD = Average Power Dissipation in Watts

 θ_{JA} = Thermal Resistance. Junction-to-Ambient in °C/W

APPENDIX C APPLYING LIFE TEST DATA

The reliability test results reported in previous sections, although obtained under severe conditions, can be extrapolated to predict failure rates expected in system applications. The conservative methods employed by Motorola in determining acceleration factors and in electrical testing permit the calculation of system level failure rates with a high level of confidence. This section details the techniques used in applying the reported data to actual system conditions.



OPERATING LIFETIME

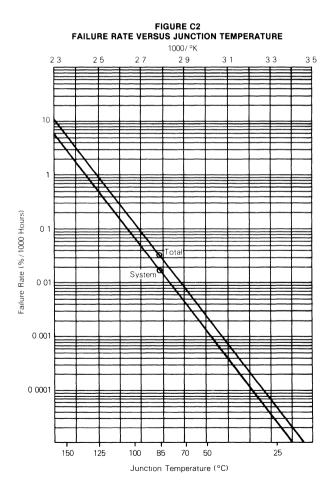
The time dependent reliability of semiconductor devices is illustrated by the "bathtub curve" of Figure C1. Three regions are presented: I, a region of relatively high declining failure rate known as "infant mortality"; II, a region of constant, random failures; and III, a region of increasing failure rate due to wear-out mechanisms. Careful attention to manufacturing details and process screens help to eliminate the effects observed in Region I. It is significant to note that wear-out phenomena have not been observed during life testing of MC68XX devices. Failure rates are expressed in percent failures-perthousand hours. Mean-Time-Between-Failures (MTBF) is another frequently used parameter which is the reciprocal of the failure rate (failures-per-hour) and is expressed in units of time.

$$MTBF = \frac{1}{\lambda}$$

The failure rate characteristics of LSI circuits may be observed in a short period of time using the accelerating effects of temperature. The Arrhenius equation described in Appendix B establishes an exponential relationship between time and temperature which permits a quantitative extrapolation of the data.

FAILURE RATE DETERMINATION

Table 2 provides 70°C failure rate values for twenty MC68XX device types. Explained in that section was the distinction between the Total Failure Rate, which includes all life test failures, and the System Failure Rate, which includes only catastrophic failures. Extrapolating this data to operating temperatures other than 70°C can be accomplished using the curves in Figure C2. For a specific device type, plot the 70°C failure rate value and corresponding junction temperature on the graph and draw a line through this point parallel to the 1 eV curves shown. This line represents the failure rate values at corresponding junction temperatures for that device type. Measure the device power dissipation at the maximum operating temperature and compute the corresponding junction temperature value using Equation 3. The failure rate for that temperature can then be determined directly from the graph and will represent the operating condition of the device in the system.



APPENDIX D ELECTRICAL TESTING AND FAILURE CHARACTERISTICS

The electrical measurements performed on life test and temperature-humidity-bias (THB) samples were obtained using Fairchild Sentry Test Systems and programs employing exhaustive functional routines under worst-case supply and clock conditions. Devices which do not meet a test criterion, including those failing for parametric reasons, are first segregated into "bin outs" defined by the test program. A data log is obtained from which each failing device is then assigned to one of six failure mode categories. An analysis to determine specific failure mechanisms is performed when the level or pattern of failure indicates that it is appropriate. THB rejects are routinely decapsulated and inspected for corrosion of the metallization.

The electrical test programs are typically constructed in the following manner:

TABLE D1 TYPICAL MC68XX ELECTRICAL TEST SEQUENCE

- 1 "Opens" test
- 2 "Shorts" test
- 3 Functionality under nominal supply and clock conditions
- 4 Input leakage
- 5 Three-State leakage
- 6 Functionality to data sheet limits during worst-case conditions of V_{DD} level and clock frequency combinations
- 7 Output buffer current drive capability
- 8 Power dissipation test

Failure modes categorized according to these tests do not always indicate a specific problem and individual test programs deviate from the sequence shown above as required for complete testing of the specific device type. Microprocessors and other LSI logic circuits do not readily lend themselves to the identification of failure modes since their complexity creates an astronomical number of possible combinations, some of which are very subtle. Attempts to categorize these modes by the test sequence invariably result in groupings which are not mutually exclusive or related to physical mechanisms.

The most valuable method of classification is a dichotomy based on system functionality. Semiconductor devices failing a rigorous electrical test frequently function adequately under nominal operating conditions such that they would not cause a system failure. These units have parameters which exceed data sheet limits, but which do not impact system reliability to the extent of catastrophic failures. Nearly half of the failures observed in life testing were non-catastrophic in nature. The ultimate classification criterion must be predicated upon the maintenance of system operation and MC68XX life test failure modes are, therefore, categorized as being either catastrophic or non-catastrophic. Opens, shorts, or functional (logic state) failure modes are considered to be catastrophic, and are used in the determination of the "System Failure Rate." Input leakage, three-state leakage, and parametric failure modes are non-catastrophic and are combined with the catastrophic failures in the "Total Failure Rate."

TABLE D2 FREQUENCY OF FAILURE MODES ON MC68XX DEPLETION-LOAD DEVICES

| Failure Modes | Opens | Shorts | Functional | Input Leakage | Three- State Leakage | Parametric |
|---------------------------|-------|--------|------------|------------------|----------------------------|------------|
| Percentage of Occurrances | 7 2% | 6 0% | 37 9% | 22 7% | 4 8% | 21 4% |

TABLE D3 DEFINITION OF FAILURE MODES

I. CATASTROPHIC MODES

- A. Opens No electrical connection between an external terminal and corresponding die circuitry (possibly intermittent) MOS inputs are normally high impedance ports and opens are detected by forward-biasing the substrate diode
- B. Shorts An unintended resistive path of relatively low value between one terminal and any other terminal
- C. Functional Failure of one or more output terminals to respond with a correct logical state under nominal supply, clock, and V_{1H}/V_{1L} levels a violation of the internal Boolean relationships defined by the circuit design

II. NON-CATASTROPHIC MODES

- A. Input Leakage A current of either polarity which exceeds data sheet limits for input terminals. Large values of leakage may be classified as shorts.
- B. Three-State Leakage A current of either polarity which exceeds data sheet limits for I/O terminals when under three-stated conditions. This parameter is also timing dependent and when catastrophic is classified as a functional failure mode.
- Parametric A broad classification of non-catastrophic failure modes which exclude leakages but include
 - 1 Failure to respond at one or more output terminals with a correct logical state under worst-case supply clock, and V_{IH}/V_{IL} conditions, usually the result of excessive propagation delays, improper V_{OH}/V_{OL} levels, noise, or a dynamic logic state which should be static, etc. Must be 100% functional under nominal conditions and may be associated with leakage currents not previously detected
 - 2 Excessive power dissipation not caused by leakage currents. Device is 100% functional
 - 3 Incorrect output analog voltage or current level not resulting in a functional failure

The distribution of failure modes and mechanisms observed during life testing appear to be the result of random manufacturing anomalies and do not, therefore, indicate trends correlatable to specific process or design deficiencies. These results are consistent with careful attention to process controls and reflect Motorola's high priority on quality and reliability.

POWER CONSIDERATIONS

The previous paragraphs have shown that circuit performance and long-term circuit reliability are affected by die temperature. Performance and reliability are both improved by keeping junction temperatures low. Electrical power dissipation by the integrated circuit causes an increase in the die temperature relative to some reference point, usually the ambient temperature. This increase in temperature depends on the amount of power dissipated in the circuit and on the thermal resistance between the heat source and the reference point. The average chip-junction temperature, TJ, in degrees C can be obtained from:

$$T_{J} = T_{A} + (P_{D} \bullet \theta_{JA})$$
Where:

 $T_A = Ambient Temperature, °C$

 θ JA = Package Thermal Resistance, Junction-to-Ambient, °C/W

PD≡PINT+PPORT

 $P_{INT} = I_{CC} \times V_{CC}$, Watts - Chip Internal Power

PPORT≡Port Power Dissipation, Watts - User Determined

For most applications PPORT ◀PINT and can be neglected. PPORT may become significant if the device is configured to drive Darlington bases or sink LED loads.

An approximate relationship between PD and TJ (if PPORT is neglected) is:

$$P_D = K + (T_J + 273 ^{\circ}C)$$
 (2)

Where K is a constant pertaining to the particular part.

Solving equations 1 and 2 for K gives:

$$K = P_{D} \bullet (T_{A} + 273 \circ C) + \theta_{JA} \bullet P_{D}^{2}$$
(3)

The constant K can be determined from equation (3) by measuring PD at the TA given in the data sheet (worst case), or by measuring PD (at equilibrium) for a known TA. Remember that power dissipation specifications on Motorola's microprocessor, single-chip microcomputer, and peripheral data sheets are specified at steady state current, maximum power supply voltage, and minimum operating temperature. The value for θ_{JA} for a particular package can be found in the data sheet. Using the calculated value for K, the values of PD and TJ can be obtained by solving equations (1) and (2) iteratively for any value of TA.

Example:

In this example the power dissipation (PD) and junction temperature (TJ) for the MC6821P are calculated for an ambient temperature (TA) of 70°C.

The MC6821P data sheet specifies PD = 0.55 W @ TA = 0°C. θ JA for a plastic 40-lead package is 100° C/W.

Solving for K:

$$K = P_{D} \cdot (T_A + 273 \,^{\circ}C) + \theta_{JA} \cdot P_{D}^2$$
 (3)
 $K = 180.4$

T_J is calculated from equation (1)

$$T_J = T_A + (P_D \cdot \theta_{JA})$$
 (1)
 $T_J = 0 \cdot C + (100 \cdot C/W)(0.55 \cdot W) = 55 \cdot C$

Equation 1 must be used to calculate TJ. This equation, however, assumes that PD at the specified TA is known. Since PD at 70°C is not known, an iterative process must be used. Since the only known PD is at 0°C, this number is used for the 1st pass iteration. Now TJ can be calculated. Once calculated, equation 2 can be used to calculate PD given the TJ calculated from equation 1. If this PD is different from the value used to calculate TJ, then another iteration is required. For successive iterations the value of PD obtained from the last iteration should be used for the next calculations. When the calculated values of PD and TJ satisfy both equations 1 and 2, the iteration is complete

First Iteration:

Equation (1)
$$T_J = T_A(P_D \cdot \theta_{JA})$$

 $T_J = 70 + (0.55)(100)$
 $T_J = 125 ^{\circ}C$

Equation (2)
$$P_D = K \div (T_J + 273^{\circ}C)$$

 $P_D = 180.4 \div (125 + 273)$
 $P_D = 0.453 \text{ W}$

Second Iteration:

Substituting PD back into equation (1):

$$T_J = 70 + (0.453)(100)$$

 $T_J = 115.3$ °C
 $P_D = 180.4 \div (115.3 + 273)$
 $P_D = 0.456$ W

Continuing in this iterative manner the values $T_J = 116.3$ °C and $P_D = 0.463$ W satisfy both equations.

I/O PORT POWER — Microcomputing units (MCUs) contain another source of power dissipation — the I/O ports (PPORT). Fortunately, PPORT becomes a significant value only if the port pin is configured to sink LED load currents or drive Darlington pair bases. If PPORT cannot be neglected, the following equation should be used to obtain a value for PPORT:

LED Drive Darlington Drive

$$PPORT = \sum (VOL) \bullet (|IIL|) + \sum (VCC - VOL) \bullet (|IOH|)$$
1
1
to
1
n
where n = # of port pins

Once a number is obtained for PPORT, it may be added directly to PD to ge a total device power dissipation value. This total value should be used in place of PD in equations (1) and (2).

INSTANTANEOUS POWER — The junction temperature rise above ambient reaches equilibrium in a few minutes due to power dissipation. This thermal response should be considered when measuring power and must be considered when measuring power as part of a high-speed test.

The maximum power demand by any device occurs during turn-on when $T_J = T_A$. The following example should be followed when calculating worst-case power supply values.

Example:

Continuing to use the MC6821P example to determine PD @ $T_A = T_J = 0$ °C,

Equation (2)
$$P_D = K \div (T_J + 273^{\circ}C)$$

 $P_D = 180.4 \div (0 + 273)$
 $P_D = 0.66 \text{ W}$

Thus, the maximum instantaneous power supply demand is 0.66 W.

SUMMARY — The calculated value of T_J should not exceed the data sheet value of T_J (maximum) for a particular IC package. If T_J (calculated) is in excess of T_J (maximum), something must be done to reduce the junction temperature. Equation (5) shows that θ_{JA} consists of two parts, θ_{JC} and θ_{CA} .

$$\theta$$
JA = θ JC + θ CA (5)
 θ JC = thermal resistance, junction-to-case, °C/W
 θ CA = thermal resistance, case-to-ambient, °C/W

Junction-to-case thermal resistance (θ JC) is a function of die construction and therefore cannot be changed. However, θ CA may be varied. Lowering θ CA can be accomplished by increasing the surface area of the package with the addition of a heat sink, or by blowing air across the package to promote improved heat dissipation. Alternatively, θ CA may be lowered by selecting a different package.

THE "BETTER" PROGRAM

Motorola standard commerical integrated circuits are manufactured under stringent in-process controls and quality inspections combined with the industry's finest outgoing quality inspections. The "BETTER" program offers three levels of extra processing, each tailored to meet different user needs at nominal costs.

The program is designed to:

- Eliminate Incoming Electrical Inspection
- Eliminate Need for Independent Test Labs and Associated Extra Time and Costs
- Reduce Field Failures
- Reduce Service Calls
- Reduce Equipment Downtime
- Reduce Board and System Rework
- Reduce Infant Mortality
- Save Time and Money
- Increase End-Customer Satisfaction

BETTER PROCESSING — STANDARD PRODUCT PLUS:

Level I (Suffix S)

- 100% temperature cycling per MIL-STD-883A. Method 1010, ten cycles from −25°C to +150°C.
- 100% high temperature functional test at + 100°C.

Level II (Suffix D)

- 100% burn-in to MIL-STD-883A test conditions equivalent to 160 hours at + 125°C.
- 100% post burn-in DC parametric test at 25°C.

Level III (Suffix DS)

Combination of Levels I and II above.

TABLE 4-5. "BETTER" AQL GUARANTEES

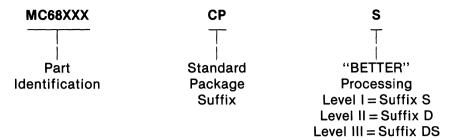
| Test | Condition | AQL | | | | |
|--------------------------------------|-----------------|---------|----------|-----------|--|--|
| lest | Condition | Level I | Level II | Level III | | |
| High Temperature Functional | $T_A = T_{Max}$ | 0.15 | 0.15* | 0.10 | | |
| DC Parametric | $T_A = 25$ °C | 0.28 | 0.28 | 0.28 | | |
| AC Parametric | $T_A = 25$ °C | 0.65 | 0.65 | 0.65 | | |
| External Visual and Mechanical | Major | 0.11 | 0.11 | 0.11 | | |
| | Minor | 2.50 | 2.50 | 2.50 | | |
| Hermeticity | Gross | 0.46 | 0.46 | 0.46 | | |
| (Not applicable to plastic packages) | | | | | | |

T_{Max} = Maximum Operating Temperature of Device Under Test *25°C

NOTES:

- Major Defects Affects Form, Fit, or Function Minor Defects — Cosmetic
- 2. General Inspection Level II

PART MARKING — The part is marked with a suffix letter(s) as shown to indicate the level of testing that the part received.



ORDERING INFORMATION — The Standard Motorola part number with the corresponding "BETTER" suffix can be ordered from your local authorized Motorola distributor or Motorola sales offices. "BETTER" pricing will be quoted as an adder to standard commercial product price.

Data Sheets

DATA SHEETS

Data sheets at Motorola are grouped into one of three categories depending on the amount of information presented. These categories are:

Product Preview — This is the first official information released about a potential device. It contains very basic information about a product and usually precedes sample devices by approximately six months. This type of data sheet is distinguished by the words "Product Preview" appearing in the header of the first page as shown in Figure 4-1.

Advanced Information — This information is released with sample devices. It contains an extensive discussion of device operation and provides complete parametric information such as Maximum Ratings, Thermal Characteristics, Electrical Characteristics, Bus Timing, and I/O Port Timing as applicable. Timing diagrams are included to support the tabular material. All of the parametric information given is the result of early testing of initial product from the manufacturing process. Values given are subject to change without notice. This type of data sheet is distinguished by the words "Advanced Information" appearing in the header of the first page as shown in Figure 4-1.

Final Data Sheet — This data sheet evolves from the Advanced Information data sheet. It is a result of test information collected from a fully-implemented manufacturing process. The parametric information has been analyzed and approved. Motorola considers this is a fully characterized device. This type of data sheet is distinguished by the absence of any designation appearing in the header of the first page as shown in Figure 4-1.

DATA SHEET ORGANIZATION

The data sheets that follow are arranged in ascending numerical order disregarding the prefix letters and any speed designation letters.

When device numbers are essentially identical as in the MC6805 and MC6809 families, the alphabetical letters used to distinguish the family members are arranged in ascending alphabetical order. When one data sheet covers closely related devices such as the MC6801, MC6803, and MC6803NR, it is sorted by the lowest part number — in this case, MC6801.

MECHANICAL DATA

The package availability for each device is indicated on the front page of the individual data sheet. Mechanical data for the different package types used is located in a separate chapter of the manual. The data is arranged by package size (pin count) and then package type (plastic, ceramic, etc.).

Figure 4-1. DATA SHEET TYPE DESIGNATIONS



3501 ED BLUESTEIN BLVD., AUSTIN, TEXAS 78721

Product Preview

8-BIT MICROCOMPUTER UNIT



3501 ED BLUESTEIN BLVD., AUSTIN, TEXAS 78721

Advance Information

16-BIT MICROPROCESSING UNIT



3501 ED BLUESTEIN BLVD., AUSTIN, TEXAS 78721

MC6847/MC6847Y VIDEO DISPLAY GENERATOR (VDG)



MC1372

COLOR TV VIDEO MODULATOR

...an integrated circuit used to generate an RF TV signal from baseband color-difference and luminance signals.

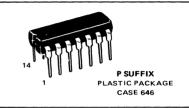
The MC1372 contains a chroma subcarrier oscillator, a lead and lag network, a quasi-quadrature suppressed carrier DSB chroma modulator, an RF oscillator and modulator, and an LSTTL compatible clock driver with adjustable duty cycle.

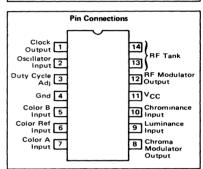
The MC1372 is a companion part to the MC6847 Video Display Generator, providing and accepting the correct dc interconnection levels. This device may also be used as a general-purpose modulator with a variety of video signal generating devices such as video games, test equipment, video tape recorders, etc.

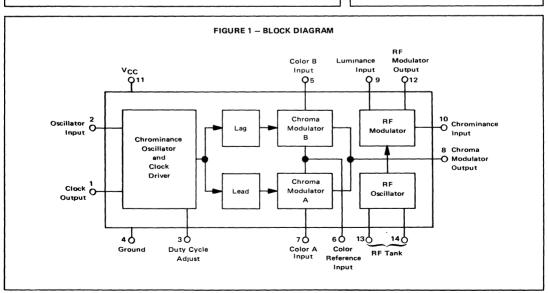
- Single 5.0 Vdc Supply Operation for NMOS and TTL Compatibility
- Minimal External Components
- Compatible with MC6847 Video Display Generator
- Sound Carrier Addition Capability
- Modulates Channel 3 or 4 Carrier with Encoded Video Signal
- Low Power Dissipation
- Linear Chroma Modulators for High Versatility
- Composite Video Signal Generation Capability
- Ground-Referenced Video Prevents Overmodulation

COLOR TV VIDEO MODULATOR CIRCUIT

SILICON MONOLITHIC INTEGRATED CIRCUIT







MAXIMUM RATINGS ($T_A = 25^{\circ}C$ unless otherwise noted)

| Rating | Value | Unit |
|---|-------------|-----------------------------|
| Supply Voltage | 8.0 | Vdc |
| Operating Ambient Temperature Range | 0 to +70 | °C |
| Storage Temperature Range | -65 to +150 | °C |
| Junction Temperature | 150 | °C |
| Power Dissipation, Package Derate above 25°C | 1 25 13 | Watts mW/ ^O C |

RECOMMENDED OPERATING CONDITIONS

| Supply Voltage | 5.0 | Vdc |
|---|-------------|-----|
| Luma Input Voltage — Sync Tip Peak White | 1 0 0 35 | Vdc |
| Color Reference Voltage | 1.5 | Vdc |
| Color A, B Input Voltage Range | 1.0 to 20 | Vdc |

ELECTRICAL CHARACTERISTICS ($V_{CC} = +5 \text{ Vdc}$, $T_A = 25^{\circ}\text{C}$, Test Circuit 1 unless otherwise noted)

| Characteristic | Mın | Тур | Max | Unit |
|--------------------------|------|-----|------|-------|
| Operating Supply Voltage | 4 75 | 5.0 | 5.25 | Volts |
| Supply Current | - | 25 | - | mA |

CHROMA OSCILLATOR/CLOCK DRIVER (Measured at Pin 1 unless otherwise noted)

| Output Voltage | (V _{OL}) | _ | _ | 0.4 | Vdc |
|--|--------------------|-----|----|-----|-----|
| | (∨ _{OH}) | 2 4 | - | - | |
| Rise Time (V1 = 0 4 to 2 4 Vdc) | | _ | - | 50 | ns |
| Fall Time (V1 = 2 4 to 0 4 Vdc) | | _ | _ | 50 | ns |
| Duty Cycle Adjustment Range (V3 = 5 0 Vdc) (Measured at V1 = 1 4 V) | | 70 | _ | 30 | % |
| Inherent Duty Cycle (No connection to Pin 3) | | _ | 50 | = | % |

CHROMA MODULATOR (V5 = V6 = V7 = 1 5 Vdc unless otherwise noted)

| Input Common Mode Voltage Range (Pins 5, 6, 7) | 0.8 | | 2 3 | Vdc |
|---|-----|-----|-----|------------|
| Oscillator Feedthrough (Measured at Pin 8) | _ | 15 | 31 | mV(p-p) |
| Modulation Angle [θ 8(V7 = 2 0 Vdc) – θ 8(V5 = 2 0 Vdc)] | 85 | 100 | 115 | degrees |
| Conversion Gain [V8/(V7 - V6), V8/(V5 - V6)] | _ | 0.6 | _ | V(p-p)/Vdc |
| Input Current (Pins 5, 6, 7) | _ | | -20 | μА |
| Input Resistance (Pins 5, 6, 7) | 100 | | _ | kΩ |
| Input Capacitance (Pins 5, 6, 7) | _ | _ | 5 0 | pF |
| Chroma Modulator Linearity (V5 = 1 0 to 2 0 V, V7 = 1 0 to 2 0 V) | - | 4 0 | _ | % |

RF MODULATOR

| AF MODULATUR | | | | |
|--|-----|------|-----|-------|
| Luma Input Dynamic Range (Pin 9, Test Circuit 2) | 0 | - | 1,5 | Volts |
| RF Output Voltage (f = 67 25 MHz, V9 = 1 0 V) | _ | 15 | _ | mVrms |
| Luma Conversion Gain $(\Delta V12/\Delta V9, V9 = 0.1 \text{ to } 1.0 \text{ Vdc})$ Test Circuit 2 | _ | 0.8 | _ | V/V |
| Chroma Conversion Gain (ΔV12/ΔV10, V10 = 1 5 Vp-p, V9 = 1 0 Vdc) Test Circuit 2 | _ | 0.95 | _ | V/V |
| Chroma Linearity (Pin 12, V10 = 1.5 Vp-p) Test Circuit 2 | | 10 | - | % |
| Luma Linearity (Pin 12, V9 = 0 to 1 5 Vdc) Test Circuit 2 | | 2 0 | _ | % |
| Input Current (Pin 9) | _ | _ | -20 | μА |
| Input Resistance (Pin 10) | _ | 800 | _ | Ω |
| Input Resistance (Pin 9) | 100 | _ | - | kΩ |
| Input Capacitance (Pins 9, 10) | _ | | 50 | pF |
| Residual 920 kHz (Measured at Pin 12) See Note 1 | _ | 50 | _ | dB |
| Output Current (Pin 12, V9 = 0 V) Test Circuit 2 | T - | 1.0 | _ | mA |

TEMPERATURE CHARACTERISTICS (V_{CC} = 5 Vdc, T_A = 0 to 70°C, IC only)

| Chroma Oscillator Deviation (f _o = 3.579545 MHz) | _ | ± 50 | - | Hz |
|---|-------|-------|---|-----|
| RF Oscillator Deviation (f _o = 67.25 MHz) | _ | ± 250 | - | kHz |
| Clock Drive Duty Cycle Stability | ± 5.0 | _ | - | % |

NOTE 1 V9 = 1.0 Vdc, V_C = 300 mV(p-p) @ 3.58 MHz,

 V_S = 250 mV(p-p) @ 4.5 MHz, Source Impedance = 75 Ω .

FIGURE 2 - TEST CIRCUIT 1

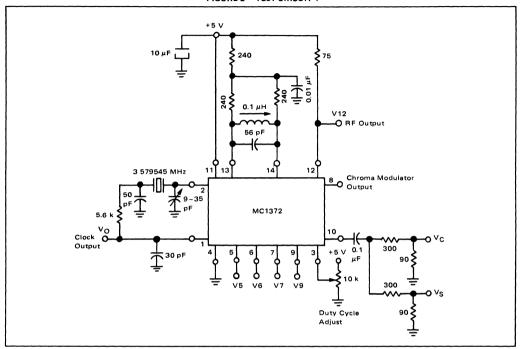


FIGURE 3 - TEST CIRCUIT 2

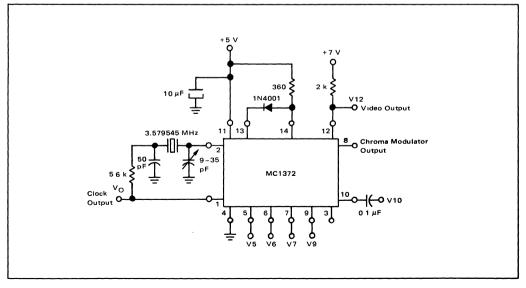
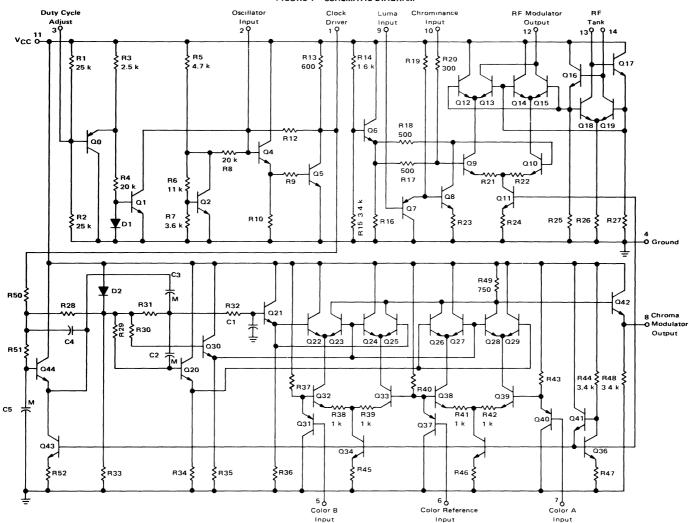


FIGURE 4 - SCHEMATIC DIAGRAM



OPERATIONAL DESCRIPTION

Pin 1 - Clock Output

Provides a rectangular pulse output waveform with frequency equal to the chrominance subcarrier oscillator. This output is capable of driving one LS-TTL load.

Pin 2 - Oscillator Input

Color subcarrier oscillator feedback input. Signal from the clock output is externally phase shifted and ac coupled to this pin.

Pin 3 - Duty Cycle Adjust

A dc voltage applied to this pin adjusts the duty cycle of the clock output signal. If the pin is left unconnected, the duty cycle is approximately 50%.

Pin 4 - Ground

Pin 5 - Color B Input

Dc coupled input to Chroma Modulator B, whose phase leads modulator A by approximately 100°. The modulator output amplitude and polarity correspond to the voltage difference between this pin and the Color Reference Voltage at Pin 6.

Pin 6 - Color Reference Input

The dc voltage applied to this pin establishes the reference voltage to which Color A and Color B inputs are compared.

Pin 7 - Color A Input

Dc coupled input to Chroma Modulator A, whose phase lags modulator B by approximately 100° . The modulator output amplitude and polarity correspond to the voltage difference between this pin and the Color Reference Voltage at Pin 6.

Pin 8 — Chroma Modulator Output

Low impedance (emitter follower) output which provides the vectorial sum of chroma modulators A and B

Pin 9 - Luminance Input

Input to RF modulator. This pin accepts a dc coupled luminance and sync signal. The amplitude of the RF signal output increases with positive voltage applied to the pin, and ground potential results in zero output (i.e., 100% modulation). A signal with positive-going sync should be used.

Pin 10 - Chrominance Input

Input to the RF modulator. This pin accepts ac coupled chrominance provided by the Chroma Modulator Output (pin 8). The signal is reduced by an internal resistor divider before being applied to the RF modulator. The resistor divider consists of a 300 ohm series resistor and a 500 ohm shunt resistor. Additional gain reduction may be obtained by the addition of external series resistance to pin 10.

Pin 11 - VCC

Positive supply voltage

Pin 12 - RF Modulator Output

Common collector of output modulator stage. Output impedance and stage gain may be selected by choice of resistor connected between this pin and dc supply.

Pins 13 and 14 - RF Tank

A tuned circuit connected between these pins determines the RF oscillator frequency. The tuned circuit must provide a low dc resistance shunt. Applying a dc offset voltage between these pins results in baseband composite video at the RF Modulator Output.

MC1372 CIRCUIT DESCRIPTION

The chrominance oscillator and clock driver consist of emitter follower Q4 and inverting amplifier Q5. Signal presented at clock driver output pin 1 is coupled to oscillator input pin 2 through an external RC and crystal network, which provides 1800 phase shift at the resonant frequency. The duty cycle of the output waveform is determined by the dc component at pin 1 internally coupled through R12 to the base of Q4. As pin 1 dc voltage increases, a smaller portion of the sinusoidal feedback signal at pin 2 exceeds the Q4 base voltage of two times VBE required for conduction. As the dc level is reduced, device Q4 and thus Q5 is turned on for a longer percentage of the cycle. Transistors Q0, Q1, Q2 and diode D1 provide the biasing network which determines the dc operating level of the oscillator. The transistor Q2 and resistors R5, R6, and R7 form a voltage reference of four times VBE at the collector of Q2. The dc voltage at pin 1 is determined by the values of R4, R8, and R12 and the applied duty cycle adjust voltage at pin 3. Since these resistors are nominally equal, the voltage at pin 1 will always approximate the dc voltage at pin 3

The oscillator signal at pin 1 is internally coupled to active filter Q44. This filter reduces the frequency content above 4 MHz. The output of the filter at the emitter of Q44 is ac coupled through C3 to the input of the lead/lag network. R32 and C1 provide approximately 50° of phase lag, while C2 and R29 provide approximately 50° of phase lead. These two quasi-quadrature waveforms are used to switch chroma modulators B and A, respectively. The transistors Q22 through Q25 and Q32-Q33 form a doubly balanced modulator. The input signal applied at pin 5 is compared to the color dc reference voltage applied at pin 6 in differential amplifier Q32-Q33. The source current provided by transistor Q34 is partitioned in transistors Q32 and Q33 according to the differential input signal. The bases of transistors Q23 and Q24 are connected to the dc reference voltage at the emitter of Q30. The bases of transistors Q22 and Q25 are connected to the phase delayed oscillator signal at the emitter of buffer transistor Q21. The differential signal currents provided by Q32 and Q33 are switched in transistors Q22 through Q25 and the resultant signal voltage is developed across R49. This signal has the phase and frequency of the oscillator signal at the emitter of Q21. The amplitude is proportional to the differential input signal applied between pins 5 and 6. Transistors Q26 through Q29 and Q38-Q39 form chroma modulator B. This modulator develops a signal voltage which is proportional to the differential voltage applied between pins 7 and 6. The phase and frequency of the output is equal to the phase advanced chroma oscillator at the emitter of buffer transistor Q20. Both chroma modulators A and B share the same output resistor, R49, so the output signal presented at the emitter of Q42 (pin 8) is the algebraic sum of modulators A and B.

The RF oscillator consists of differential amplifier Q18 and Q19 cross-coupled through emitter followers Q16 and Q17. The oscillator will operate at the parallel resonant frequency of the network connected between pins 13 and 14. The oscillator output is used to switch the doubly balanced RF modulator, Q9 through Q15. Transistors Q7 and Q8 provide level shifting and a high input impedance to the luminance input pin 9. The bases of transistors Q9 and Q10 are both biased through resistors R17 and R18, respectively, to the same do reference voltage at Q6 emitter. The base voltage at Q10 may only be offset in a negative direction by luminance signal current source Q8. This design insures that overmodulation due to the luminance signal will never occur. The chrominance signal developed at pin 8 is externally ac coupled to pin 10 where it is reduced by resistor dividers R20 and R17, and added to the luminance signal in Q9. The resultant differential composite video currents are switched at the appropriate RF frequency in Q12 through Q15. The output signal current is presented at pin 12.

Transistors Q36, Q41 and resistors R44, R47 provide a highly stable voltage reference for biasing current sources Q43, Q34, Q35, and Q11.

MC1372 APPLICATION INFORMATION

Chrominance Oscillator

The oscillator is used as a clock signal for driving associated external circuitry, in addition to providing a switching signal for the chroma modulators. The IC uses an external crystal in a Colpitts configuration, as shown in Figure 5. Resistor R1 provides current limiting to reduce the signal swing. Capacitor C2 is adjusted for the exact frequency desired (3.579545 MHz).

In some applications, the duty cycle of the clock signal at pin 1 must be modified to overcome gate delays in

associated equipment. The duty cycle may be adjusted by varying the dc voltage applied to pin 3. This adjustment may be made with the use of a potentiometer (10 k Ω) between supply and ground. With no connection to pin 3, the duty cycle is approximately 50%.

Chroma Modulator

The chrominance oscillator is internally phase shifted and applied to chroma modulators A and B. No external lead/lag networks are necessary. The phase relationship between the modulators is approximately 100°, which was chosen to provide the best rendition of colors using equal amplitude color-difference signals. The voltage applied to pin 5, 6, or 7 must always be within the Input Common Mode Voltage Range. Since the amplitude of chrominance output is proportional to the voltage difference between pins 5 and 6 or 7 and 6, it is desirable to select the Color Reference Voltage applied to pin 6 to be midway between $V5_{max}$ and $V5_{min}$ (which should be V7_{max} and V7_{min}). The Chroma B Modulator will be defined as a (B-Y) modulator if a burst flag signal is applied to the Color B Input (pin 5) at the appropriate time. This voltage should be negative with respect to the Color Reference Voltage, and typically has an amplitude equal to $1/2[V6-V5_{min}]$. Since the phase of burst is always defined as -(B-Y), the Chroma A Modulator approximates an (R-Y) modulator; however, the phase is offset by 100 from the nominal 900, to provide the 1000 phase shift as discussed previously.

RF Modulator and Oscillator

The coil and capacitor connected between pins 13 and 14 should be selected to have a parallel resonance at the carrier frequency of the desired TV channel. The values of 56 pF and 0.1 μ H shown in Figure 5 were chosen for a Channel 4 carrier frequency of 67.25 MHz. For Channel 3 operation, the resonant frequency should be 61.25 MHz (C = 75 pF, L = 0.1 μ H). Resistors R4 and R5 are chosen to provide an adequate amplitude of switching voltage, whereas R6 is used to lower the maximum dc level of switching voltage below VCC, thus preventing saturation within the IC.

Composite Luminance and Sync should be dc coupled to Luminance Input, pin 9. This signal must be within the Luma Input Dynamic Range to insure Innearity. Since an increase in dc voltage applied to pin 9 results in an increase in RF output, the input signal should have positive-going sync to generate an NTSC compatible signal. As long as the input signal is positive, overmodulation is prevented by the integrated circuit.

Chrominance information should be ac coupled to Chrominance Input, pin 10. This pin is internally connected to a resistor divider consisting of a series 300 ohms and a shunt 500 ohms resistor. The input impedance is thus 800 ohms, and a coupling capacitor should be appropriately chosen.

+5 Vdc Clock in RF VSB Filter Output MC6847 R6 240 Video Display MC1372 R4 Generator Color B Color TV 240 Video Modulator Color Ref 56 Color A una and Sync R5 10 67 25 MHz 240 Ch 4 R2 750

FIGURE 5 - TYPICAL APPLICATION CIRCUIT

The Luminance to Chrominance ratio (L:C) may be modified with the addition of an external resistor in series with pin 10 (as shown in Figure 5). The unmodified L:C (A_O) is determined by the ratio of the respective Conversion Gain for equal amplitude signals (typically, 0.883 = -1.6~dB). The modified L:C will be governed by the equation $A_O(1~+~R_{\text{ext}}/800)$ for equal amplitude input signals.

The internal chrominance modulators are not internally connected to the RF modulator; therefore, the user has the option of connecting an externally generated chrominance signal to the RF modulator. In addition, the RF modulator is wideband, and a 4.5 MHz FM audio signal may be added to the chrominance input at pin 10. This may be accomplished by selecting an appropriate series input resistor to provide the correct Luminance:Sound ratio.

The modulated RF signal is presented as a current at RF Modulator Output, pin 12. Since this pin represents a current source, any load impedance may be selected for matching purposes and gain selection, as long as the vol-

tage at pin 12 is high enough to prevent the output devices from reaching saturation (approximately 4.5 V with components in Figure 5). The peak current out of pin 12 is typically 2 mA. Hence, a load resistance of up to 250 ohms may be safely used with a 5 V supply.

Composite Video Signal Generation

The RF modulator may be easily used as a composite video generator by replacing the RF oscillator tank circuit with a diode as shown in Figure 3. This results in the output modulator being biased so the summation of luminance and chrominance appears unswitched at pin 12. The polarity of the output waveform is controlled by the direction of the diode. *Inverted video:* Anode to pin 14, cathode to pin 13. *Non-inverted video:* Anode to pin 13, cathode to pin 14. Note that the supply resistor must always be connected to the anode of the diode.

The amplitude of signal may be increased by increasing the load resistor on pin 12 and returning it to a higher supply voltage. Any voltage up to the Absolute Maximum Rating may be used.

Applications with MC6847 Video Display Generator

The MC1372 may be easily interfaced to the MC6847 as shown in Figure 5. The dc levels generated and required by the VDG are compatible with the MC1372, so that pins 1, 5, 6, 7, and 9 may be directly coupled to the appropriate MC6847 pins. Both integrated circuits as well as any associated NMOS MPU may be driven from a common 5 Vdc supply.

Recommended Chroma-Luma Signals

A chroma modulation angle of 100° was chosen to facilitate a desirable selection of colors with a minimum number of input signal levels. The following table demonstrates applicable signal levels for a variety of colors.

RECOMMENDED CHROMA-LUMA SIGNALS

| | Pin #9 Luminance Input (Vdc) | Pin #7 Color A (Vdc) | Pin #6 Color Ref. (Vdc) | Pın #5 Color B (Vdc) |
|----------|---------------------------------------|----------------------|-------------------------------|----------------------------|
| Sync | 10 | 1.5 | 1.5 | 1.5 |
| Blanking | 0 75 | 1.5 | 1.5 | 1.5 |
| Burst | 0.75 | 1.5 | 1.5 | 1.25 |
| Black | 0.70 | 1.5 | 1.5 | 1.5 |
| Green | 0.50 | 1.0 | 1.5 | 1.0 |
| Yellow | 0.38 | 1.5 | 1.5 | 1.0 |
| Blue | 0.62 | 15 | 1.5 | 20 |
| Red | 0 62 | 2.0 | 1.5 | 15 |
| Cyan | 0 50 | 10 | 1 5 | 15 |
| Magenta | 0 50 | 20 | 1.5 | 2.0 |
| Orange | 0 50 | 20 | 1.5 | 10 |
| Buff | 0 38 | 1 5 | 1.5 | 1.5 |

OUTLINE DIMENSIONS

THERMAL INFORMATION

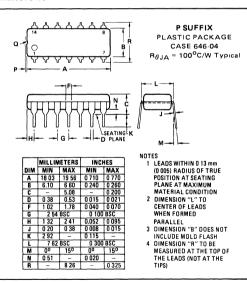
The maximum power consumption an integrated circuit can tolerate at a given operating ambient temperature can be found from the equation

$$P_{D}(T_{A}) = \frac{T_{J(max)} - T_{A}}{R_{\theta JA}(typ)}$$

where $P_{D(T_A)}$ = Power Dissipation allowable at a given operating ambient temperature. This must be greater than the sum of the products of the supply voltages and supply currents at the worst-case operating condition

T_{J(max)} = Maximum Operating Junction Temperature as listed in the Maximum Ratings Section

 T_{A} = Maximum Desired Operating Ambient Temperature $R_{\theta,JA}(typ)$ = Typical Thermal Resistance Junction to Ambient





MC3446A

QUAD GENERAL-PURPOSE INTERFACE BUS (GPIB) TRANSCEIVER

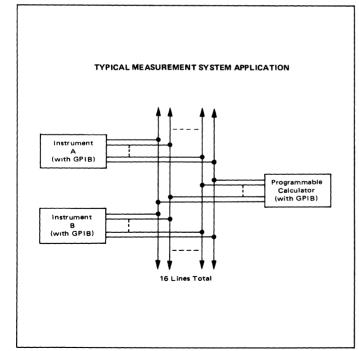
The MC3446A is a quad bus transceiver intended for usage in instruments and programmable calculators equipped for interconnection into complete measurement systems. This transceiver allows the bidirectional flow of digital data and commands between the various instruments. The transceiver provides four open-collector drivers and four receivers featuring hysteresis.

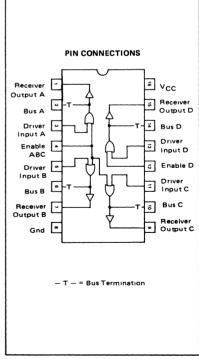
- Tailored to Meet the IEEE Standard 488-1978 (Digital Interface for Programmable Instrumentation) and the Proposed IEC Standard on Instrument Interface
- Provides Electrical Compatibility with General-Purpose Interface Bus (GPIB)
- MOS Compatible with High Impedance Inputs
- Driver Output Guaranteed Off During Power Up/Power Down
- Low Power Average Power Supply Current = 12 mA
- Terminations Provided

QUAD INTERFACE BUS TRANSCEIVER SILICON MONOLITHIC INTEGRATED CIRCUIT



P SUFFIX
PLASTIC PACKAGE
CASE 648





MAXIMUM RATINGS (T_A = 25°C unless otherwise noted.)

| Rating | Symbol | Value | Unit |
|-------------------------------------|-------------------|-------------|------|
| Power Supply Voltage | Vcc | 7.0 | Vdc |
| Input Voltage | V _I | 5.5 | Vdc |
| Driver Output Current | ¹ O(D) | 150 | mA |
| Junction Temperature | ΤJ | 150 | °c |
| Operating Ambient Temperature Range | TA | 0 to +70 | °c |
| Storage Temperature Range | T _{stg} | -65 to +150 | °c |

ELECTRICAL CHARACTERISTICS

(Unless otherwise noted, 4.5 V \leq V_{CC} \leq 5.5 V and 0 \leq T_A \leq 70°C, typical values are at T_A = 25°C, V_{CC} = 5.0 V)

| Charac | teristic | Symbol | Min | Тур | Max | Unit |
|--|---|--------------------|------------------|-------------|---------------------|------|
| DRIVER PORTION | | | | | | |
| Input Voltage - High Logic State | | V _{IH(D)} | 2.0 | _ | _ | V |
| Input Voltage - Low Logic State | | VIL(D) | _ | _ | 0.8 | V |
| Input Current — High Logic State (V _{IH} = 2 4 V) | | IH(D) | _ | 50 | 40 | μА |
| Input Current - Low Logic State (V _{IL} = 0.4 V, V _{CC} = 5 0 V, T _A = | 25°C) | lL(D) | - | -0.2 | -0.25 | mA |
| Input Clamp Voltage (I _{IK} = -12 mA) | | VIK(D) | - | - | -1.5 | V |
| Output Voltage - High Logic State (1 (VIH(S) = 2.4 V or VIH(D) = 2.0 | | VOH(D) | 2.5 | 3 3 | 3 7 | V |
| Output Voltage - Low Logic State (VIL(S) = 0 8 V, VIL(D) = 0 8 V, | I _{OL(D)} = 48 mA) | V _{OL(D)} | - | - | 0.5 | |
| Input Breakdown Current (V _{I(D)} = 5.5 V) | | IB(D) | | - | 10 | mA |
| RECEIVER PORTION | | | | | | |
| Input Hysteresis | | _ | 400 | 625 | _ | mV |
| Input Threshold Voltage — Low to Hi | gh Output Logic State | VILH(R) | | 1.66 | 2.0 | V |
| Input Threshold Voltage — High to Lo | ow Output Logic State | VIHL(R) | 0.8 | 1.03 | | V |
| Output Voltage — High Logic State (V _{IH} (R) = 20 V, I _{OH} (R) = -400 µ | (A) | VOH(R) | 2.4 | - | - | V |
| Output Voltage - Low Logic State (V _{IL(R)} = 0 8 V, I _{OL(R)} = 8 0 m/s | A) | VOL(R) | _ | _ | 0.5 | V |
| Output Short-Circuit Current (V _{IH(R)} = 2 0 V) (Only one outpu | t may be shorted at a time) | los(R) | 40 | - | 14 | mA |
| BUS LOAD CHARACTERISTICS | | | | | | |
| | (V _{IH(E)} = 24 V) (I _{BUS} = -12 mA) | V _(BUS) | 2 5 - | 3 3 - | 3 7 -1 5 | V |
| | (V _{IH} (D)= 24 V, V _{BUS} ≥ 5 0 V) (V _{IH} (D) = 24 V, V _{BUS} = 0.5 V) (V _{BUS} ≤ 5.5 V) (V _{CC} = 0, 0 V ≤ V _{BUS} ≤ 2 75 V) | I(BUS) | 0 7 -1 3 - | - - - | -3 2 2 5 0.04 | mA |
| TOTAL DEVICE POWER CONSUMP | TION | | | | | |
| Power Supply Current (All Drivers OFF) (All Drivers ON) | | Icc | - - | 12 32 | 19 40 | mA |

SWITCHING CHARACTERISTICS ($V_{CC} = 5.0 \text{ V}, T_A = 25^{\circ}\text{C}$)

| Characteristic | Symbol | Min | Тур | Max | Unit |
|---|---------|-----|-----|-----|------|
| DRIVER PORTION | | | | | |
| Propagation Delay Time from Driver Input to Low Logic State Bus Output | tPHL(D) | _ | - | 50 | ns |
| Propagation Delay Time from Driver Input to High Logic State Bus Output | tPLH(D) | _ | - | 40 | ns |
| Propagation Delay Time from Enable Input to Low Logic State Bus Output | tPHL(E) | _ | | 50 | ns |
| Propagation Delay Time from Enable Input to High Logic State Bus Output | tPLH(E) | - | | 50 | ns |
| RECEIVER PORTION | | | | | |
| Propagation Delay Time from Bus Input to High Logic State Receiver Output | tPLH(R) | - | _ | 50 | ns |
| Propagation Delay Time from Bus Input to Low Logic State Receiver Output | tPHL(R) | _ | _ | 40 | ns |

FIGURE 1 – TEST CIRCUIT AND WAVEFORMS FOR PROPAGATION DELAY TIME FROM RECEIVER INPUT (BUS) TO OUTPUT

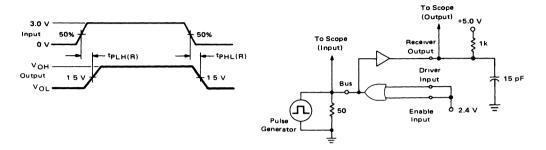
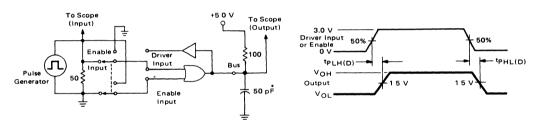
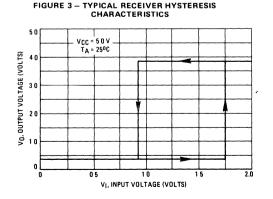
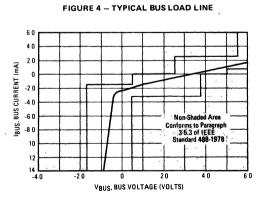


FIGURE 2 – TEST CIRCUIT AND WAVEFORMS FOR PROPAGATION DELAY TIME FROM DRIVER AND COMMON ENABLE INPUTS TO OUTPUT (BUS)



^{*} Includes Probe and Jig Capacitance







MC3447

BIDIRECTIONAL INSTRUMENTATION BUS (GPIB) TRANSCEIVER

This bidirectional bus transceiver is intended as the interface between TTL or MOS logic and the IEEE Standard Instrumentation Bus (488-1978, often referred to as GPIB). The required bus termination is internally provided.

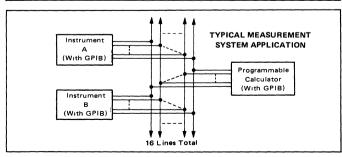
Low power consumption has been achieved by trading a minimum of speed for low current drain on non-critical channels. A fast channel is provided for critical ATN and EOI paths.

Each driver/receiver pair forms the complete interface between the bus and an instrument. Either the driver or the receiver of each channel is enabled by a Send/Receive input with the disabled output of the pair forced to a high impedance state. The receivers have input hysteresis to improve noise margin, and their input loading follows the bus standard specifications.

- Low Power Average Power Supply Current = 30 mA Listening 75 mA Talking
- Eight Driver/Receiver Pairs
- Three-State Outputs
- High Impedance Inputs
- Receiver Hysteresis 600 mV (Typ)
- Fast Propagation Times 15-20 ns (Typ)
- TTL Compatible Receiver Outputs
- Single +5 Volt Supply
- Open Collector Driver Output with Terminations
- Power Up/Power Down Protection (No Invalid Information Transmitted to Bus)
- No Bus Loading When Power is Removed From Device
- Required Termination Characteristics Provided

$\textbf{MAXIMUM RATINGS} \ \, (\textbf{T}_{A} = 25^{o}\textbf{C} \ \, \text{unless otherwise noted})$

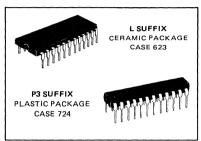
| Rating | Symbol | Value | Unit |
|-------------------------------------|------------------|-------------|------|
| Power Supply Voltage | Vcc | 70 | Vdc |
| Input Voltage | Vı | 5.5 | Vdc |
| Driver Output Current | 10(D) | 150 | mA |
| Junction Temperature | Tj | 150 | °C |
| Operating Ambient Temperature Range | TA | 0 to +70 | °C |
| Storage Temperature Range | T _{stg} | -65 to +150 | °C |

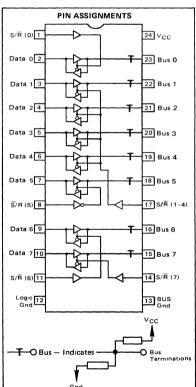


OCTAL BIDIRECTIONAL BUS TRANSCEIVER WITH

TERMINATION NETWORKS

SILICON MONOLITHIC INTEGRATED CIRCUIT





ELECTRICAL CHARACTERISTICS

(Unless otherwise noted 4 50 V \leq V $_{CC}$ \leq 5 50 V and 0 \leq T $_{A}$ \leq 70 o C, typical values are at T $_{A}$ = 25 o C, V $_{CC}$ = 5 0 V)

| Characteristic Note 2 | Symbol | Min | Тур | Max | Unit |
|---|----------------------|------|----------|-------|------|
| Bus Voltage | | | | | V |
| (Bus Pin Open)($V_{I(S/\overline{R})} = 0.8 \text{ V}$) | V(Bus) | 25 | - | 3.7 | |
| $(I_{(Bus)} = -12 \text{ mA})$ | V _{IC(Bus)} | _ | - | -15 | |
| Bus Current | I(Bus) | | | | mA |
| (5 0 V ≤ V _(Bus) ≤ 5 5 V) | (503) | 0 7 | - 1 | 2.5 | |
| $(V_{(Bus)} = 0.5 V)$ | | -1.3 | - | -3 2 | |
| $(V_{CC} = 0 \text{ V}, 0 \text{ V} \le V_{(Bus)} \le 2.75 \text{ V})$ | | - | - | +0 04 | |
| Receiver Input Hysteresis | _ | 400 | 600 | _ | mV |
| $(V_{I(S/\overline{R})} = 0.8 V)$ | 1 | | 1 | 1 | |
| Receiver Input Threshold | | | | | V |
| $(V_{I(S/\overline{R})} = 0.8 \text{ V})$ Low to High | VILH(R) | _ | 16 | 20 | |
| High to Low | VIHL(R) | 08 | 10 | - | |
| Receiver Output Voltage — High Logic State | V _{OH(R)} | 24 | _ | _ | V |
| $(V_{I(S/\overline{R})} = 0.8 \text{ V}, I_{OH(R)} = -200 \mu A, V_{(Bus)} = 2.0 \text{ V})$ | | | 1 | 1 | |
| Receiver Output Voltage — Low Logic State | Vol(R) | _ | _ | 0.5 | V |
| $(V_{I(S/\overline{R})} = 0.8 \text{ V}, I_{OL(R)} = 4.0 \text{ mA}, (V_{(Bus)} = 0.8 \text{ V})$ | 1 | | 1 | 1 | |
| Receiver Output Short Circuit Current | los(R) | -40 | _ | -20 | mA |
| $(V_{1(S/\overline{R})} = 0.8 \text{ V}, V_{(Bus)} = 2.0 \text{ V})$ | 30, | | ł | 1 | |
| Driver Input Voltage - High Logic State | V _{IH(D)} | 20 | _ | _ | V |
| $(V_{I(S/\overline{R})} = 20 \text{ V})$ | 1 | | | 1 | |
| Driver Input Voltage — Low Logic State | V _{IL(D)} | | | 0.8 | V |
| $(V_{I(S/\overline{R})} = 20 \text{ V})$ | 1 | | | | |
| Driver Input Current — Data Pins | + | | † | 1 | μА |
| $(V_{I(S/\overline{R})} = 20 \text{ V})$ | | | ļ | | |
| (0 5 ≤ V _{I(D)} ≤ 2 7 V) | 1(D) | -100 | _ | 40 | |
| $(V_{I(D)} = 55 V)$ | IB(D) | | - | 200 | |
| Input Current - Send/Receive | _ | | | 1 | μА |
| $(0.5 \le V_{I(S/R)} \le 2.7 V)$ | 1(S/R) | -250 | _ | 20 | |
| $(V_{1(S/\overline{R})} = 55 V)$ | IB(S/R) | | _ | 100 | |
| Driver Input Clamp Voltage | V _{IC(D)} | _ | | -1 5 | V |
| $(V_{1(S/\overline{R})} = 20 V, I_{1C(D)} = -18 mA)$ | 1 .0(2) | | 1 | | |
| Driver Output Voltage High Logic State | V _{OH(D)} | 2 5 | | | V |
| $(V_{IS/\overline{R}}) = 20 \text{ V}, V_{IH(D)} = 2.0 \text{ V})$ | 311(2) | | 1 | | |
| Driver Output Voltage - Low Logic State (Note 1) | V _{OL(D)} | | _ | 0.5 | V |
| $(V_{1(S/\overline{R})} = 20 \text{ V}, V_{1L(D)} = 0.8 \text{ V}, I_{OL(D)} = 48 \text{ mA})$ | 02.07 | | 1 | 1 | |
| Power Supply Current | | | | | mA |
| (Listening Mode — All Receivers On) | ICCL | _ | 30 | 45 | |
| (Talking Mode — All Drivers On) | ССН | | 75 | 95 | |

SWITCHING CHARACTERISTICS (V_{CC} = 5 0 V, T_A = 25°C unless otherwise noted)

| | | | | ns |
|---------|-----------------------------------|---|---|---|
| tPLH(D) | - | 70 | 15 | |
| tPHL(D) | _ | 16 | 30 | |
| | | | | ns |
| tPLH(R) | - | 28 | 50 | |
| tPHL(R) | - | 15 | 30 | |
| | , | | | ns |
| tPLH(R) | _ | 17 | 30 | |
| tPHL(R) | | 12 | 22 | |
| | tPHL(D) tPLH(R) tPHL(R) tPLH(R) | tPHL(D) — tPLH(R) — tPHL(R) — tPLH(R) — | tPHL(D) — 16 tPLH(R) — 28 tPHL(R) — 15 tPLH(R) — 17 | tPHH(R) - 16 30 tPLH(R) - 28 50 tPHL(R) - 15 30 |

NOTES 1. The IEEE 488-1978 Bus Standard changes $V_{OL(D)}$ from 0.4 to 0.5 V maximum to permit the use of Schottky technology

- 2 Specified test conditions for $V_{1\{S/\overline{R}\}}$ are 0.8 V (Low) and 2.0 V (High) Where $V_{1\{S/\overline{R}\}}$ is specified as a test condition, $V_{1\{S/\overline{R}\}}$ uses the opposite logic levels
- 3. In order to meet the IEEE 488-1978 standard for total system delay on the ATN and EOI channels, a fast receiver has been provided on Channel 6 (pins 9 and 16).

SWITCHING CHARACTERISTICS (continued) ($V_{CC} = 5.0 \text{ V}$, $T_A = 25^{\circ}\text{C}$ unless otherwise noted)

| Characteristic | Symbol | Min | Тур | Max | Unit |
|--|---------|-----|-----|-----|------|
| Propagation Delay Time - Send/Receiver to Data | | | | | ns |
| Logic High to Third State | tPHZ(R) | _ | 15 | 30 | |
| Third State to Logic High | tPZH(R) | _ | 15 | 30 | 1 |
| Logic Low to Third State | tPLZ(R) | | 15 | 25 | |
| Third State to Logic Low | tPZL(R) | - | 10 | 25 | 1 |
| Propagation Delay Time - Send/Receiver to Bus | | | 1 | | ns |
| Logic Low to Third State | tPLZ(D) | _ | 13 | 25 | |
| Third State to Logic Low | tPZL(D) | _ | 30 | 50 | |

PROPAGATION DELAY TEST CIRCUITS AND WAVEFORMS

FIGURE 1 - BUS INPUT TO DATA OUTPUT (RECEIVER) To Scope (Output) 3 0 V Input To Scope 0.0 (Input) Data tPLH(R) tPHL(R) Voн Output 1N916 15 \ Bus or Equiv VOL f = 1 0 MHz $t_{TLH} = t_{THL} \le 5 \text{ 0 ns (10-90)}$ 51 Duty Cycle = 50% Pulse Send/ *Includes Jig

Rec

and Probe Capacitance

FIGURE 2 - DATA INPUT TO BUS OUTPUT (DRIVER)

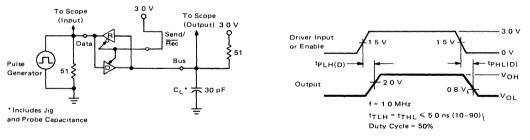
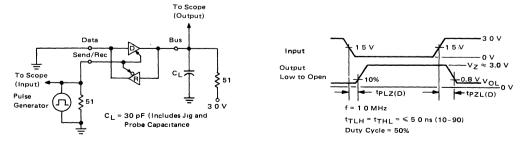


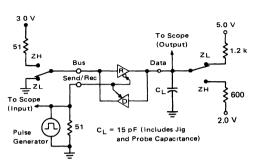
FIGURE 3 - SEND/RECEIVE INPUT TO BUS OUTPUT (DRIVER)



٥L

0.5

FIGURE 4 - SEND/RECEIVE INPUT TO DATA OUTPUT (RECEIVER)



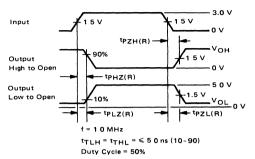


FIGURE 5 – TYPICAL RECEIVER HYSTERESIS CHARACTERISTICS

50

V_{CC} = 50 V

T_A = 250 C

VI, INPUT VOLTAGE (VOLTS)

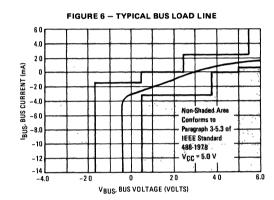


FIGURE 7 - SUGGESTED PRINTED CIRCUIT BOARD LAYOUT USING MC3447s AND MC68488

20

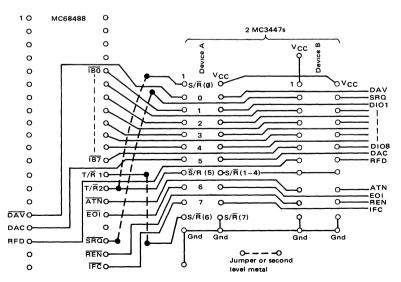




FIGURE 8 - SIMPLE SYSTEM CONFIGURATION

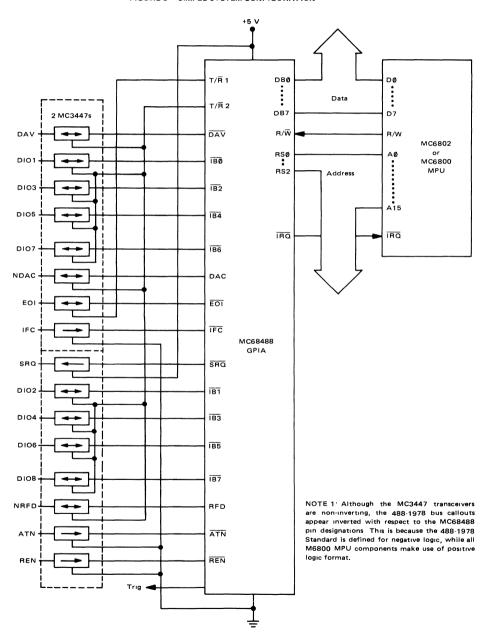
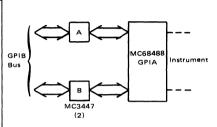
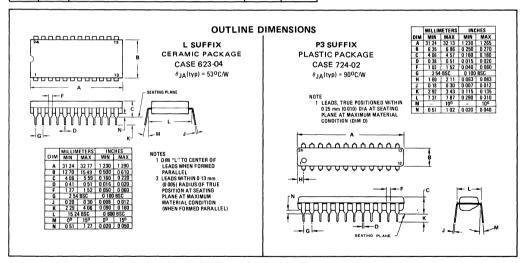


FIGURE 9 - SUGGESTED PIN DESIGNATIONS FOR USE WITH MC68488

| | 88488 ections | MC3447 Pin Designations | | | | | | | | 8488 ections |
|-------|------------------|-------------------------|----|---------------------|----|-----------------|-------|-------|--|-----------------|
| Α | В | | | | | | | В | | |
| T/R 2 | vcc | S/R (0) | 1 | | 24 | v _{cc} | Уcc | vcc | | |
| DAV | SRO | Data 0 0 | 2 | | 23 | Bus 0 | DAV | SRQ | | |
| IBØ | IB1 | Data 1 | 3 | | 22 | Bus 1 | DIO 1 | DIO 2 | | |
| īB2 | ĪB3 | Data 2 | 4 | | 21 | Bus 2 | DIO 3 | DIO 4 | | |
| īB4 | īB5 | Data 3 | 5 | | 20 | Bus 3 | DIO 5 | DIO 6 | | |
| īB6 | ĪB7 | Data 4 | 6 | Octal | 19 | Bus 4 | DIO 7 | B 010 | | |
| DAC | RFD | Data 5 | 7 | GPIB Transceiver | 18 | Bus 5 | NDAC | NRFD | | |
| T/R 2 | T/R 2 | S/R (5) | 8 | | 17 | S/R (1-4) | T/R 2 | T/R 2 | | |
| EOI | ĀTN | Data 6 | 9 | | 16 | Bus 6 | EOI | ATN | | |
| ĪFC | REN | Data 7 | 10 | | 15 | Bus 7 | IFC | REN | | |
| T/R 1 | Gnd | S/R (6) | 11 | | 14 | S/R (7) | Gnd | Gnd | | |
| Gnd | Gnd | Logic Gnd | 12 | | 13 | Bus Gnd | Gnd | Gnd | | |





THERMAL INFORMATION

The maximum power consumption an integrated circuit can tolerate at a given operating ambient temperature, can be found from the equation

$$P_{D(T_A)} = \frac{T_{J(max)} - T_A}{R_{\theta JA}(Typ)}$$

Where $P_{D(T_A)}$ = Power Dissipation allowable at a given operating ambient temperature. This must be greater than

the sum of the products of the supply voltages and supply currents at the worst case operating condition

T_{J(max)} = Maximum Operating Junction Temperature as listed in the Maximum Ratings Section

TA = Maximum Desired Operating Ambient Temperature

 $R_{\theta JA}(Typ)$ = Typical Thermal Resistance Junction to Ambient



MC3448A

BIDIRECTIONAL INSTRUMENTATION BUS (GPIB) TRANSCEIVER

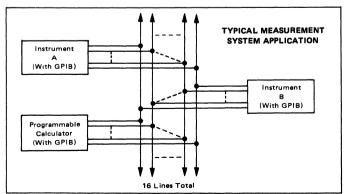
This bidirectional bus transceiver is intended as the interface between TTL or MOS logic and the IEEE Standard Instrumentation Bus (488-1978, often referred to as GPIB). The required bus termination is internally provided.

Each driver/receiver pair forms the complete interface between the bus and an instrument. Either the driver or the receiver of each channel is enabled by its corresponding Send/Receive input with the disabled output of the pair forced to a high impedance state. An additional option allows the driver outputs to be operated in an open collector⁽¹⁾ or active pull-up configuration. The receivers have input hysteresis to improve noise margin, and their input loading follows the bus standard specifications.

- Four Independent Driver/Receiver Pairs
- Three-State Outputs
- High Impedance Inputs
- Receiver Hysteresis 600 mV (Typ)
- Fast Propagation Times 15–20 ns (Typ)
- TTL Compatible Receiver Outputs
- Single +5 Volt Supply
- Open Collector Driver Output Option(1)
- Power Up/Power Down Protection
 - (No Invalid Information Transmitted to Bus)
- No Bus Loading When Power Is, Removed From Device
- Required Termination Characteristics Provided
- (1) Selection of the "Open Collector" configuration, in fact, selects an open collector device with a passive pull-up load/termination which conforms to Figure 7, IEEE 488-1978 Bus Standard.

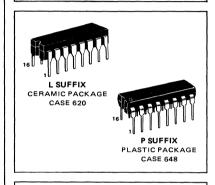
MAXIMUM RATINGS (T_A = 25°C unless otherwise noted)

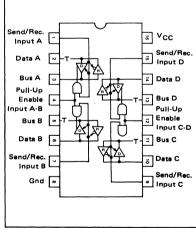
| Rating | Symbol | Value | Unit |
|-------------------------------------|------------------|-------------|------|
| Power Supply Voltage | Vcc | 7.0 | Vdc |
| Input Voltage | VI | 5.5 | Vdc |
| Driver Output Current | 10(D) | 150 | mA |
| Junction Temperature | TJ | 150 | °C |
| Operating Ambient Temperature Range | TA | 0 to +70 | °С |
| Storage Temperature Range | T _{stg} | -65 to +150 | °c |



QUAD THREE-STATE BUS TRANSCEIVER WITH TERMINATION NETWORKS

SILICON MONOLITHIC INTEGRATED CIRCUIT





| Send/Rec | Enable | Info. Flow | Comments |
|----------|--------|------------|----------------|
| 0 | × | Bus → Data | |
| 1 | 1 | Data → Bus | Active Pull-Up |
| 1 | 0 | Data → Bus | Open Col. |

ELECTRICAL CHARACTERISTICS

(Unless otherwise noted 4.75 V \leq V_{CC} \leq 5.25 V and 0 \leq T_A \leq 70°C; typical values are at T_A = 25°C, V_{CC} = 5.0 V)

| Characteristic | Symbol | Min | Тур | Max | Unit |
|---|--------------------|-------------|--------------|-------|------|
| Bus Voltage | | | | | V |
| (Bus Pin Open)($V_{I(S/R)} = 0.8 \text{ V}$) | V(BUS) | 2.75 | - | 3.7 | |
| (I _(BUS) = -12 mA) | VIC(BUS) | - | - | -1.5 | 1 |
| Bus Current | I(BUS) | | | | mA |
| (5.0 V ≤ V _(BUS) ≤ 5.5 V) | (200) | 0.7 | _ | 2.5 | |
| (V _(BUS) = 0.5 V) | i | -1.3 | _ | -3.2 | |
| $(V_{CC} = 0 \text{ V}, 0 \text{ V} \le V_{(BUS)} \le 2.75 \text{ V})$ | | - | _ | +0.04 | |
| Receiver Input Hysteresis | | 400 | 600 | | mV |
| $(V_{1(S/R)} = 0.8 \text{ V})$ | | | | | l |
| Receiver Input Threshold | | | | | V |
| $(V_{I(S/R)} = 0.8 \text{ V, Low to High})$ | VILH(R) | - | 1.6 | 1.8 | |
| $(V_{I(S/R)} = 0.8 \text{ V, High to Low})$ | VIHL(R) | 0.8 | 1.0 | - | |
| Receiver Output Voltage - High Logic State | V _{OH(R)} | 2.7 | - | _ | V |
| $(V_{1(S/R)} = 0.8 \text{ V}, I_{OH(R)} = -800 \mu\text{A}, V_{(BUS)} = 2.0 \text{ V})$ | | | | | |
| Receiver Output Voltage — Low Logic State | VOL(R) | | | 0.5 | V |
| $(V_{1(S/R)} = 0.8 \text{ V}, I_{OL(R)} = 16 \text{ mA}, V_{(BUS)} = 0.8 \text{ V})$ |) 02(11) | | | | |
| Receiver Output Short Circuit Current | IOS(R) | -15 | | -75 | mA |
| (V _{I(S/R)} = 0.8 V, V _(BUS) = 2.0 V) | 103(11) | 1 | 1 | | |
| Driver Input Voltage - High Logic State | VIH(D) | 2.0 | | | V |
| (V _{I(S/R)} = 2.0 V) | THIO | | | | 1 |
| Driver Input Voltage — Low Logic State | VIL(D) | | | 0.8 | V |
| (V _{I(S/R)} = 2.0 V) | I VIL(D) | | [| 0.0 | · |
| Driver Input Current — Data Pins | | <u> </u> | | | μΑ |
| (V _I (S/R) = V _I (E) = 20 V) | | ŀ | l | | |
| $(0.5 \le V_{I(D)} \le 2.7 \text{ V})$ | 1(D) | -200 | l _ | 40 | } |
| $(V_{I(D)} = 5.5 \text{ V})$ | IB(D) | _ | _ | 200 | |
| Input Current — Send/Receive | 10(0) | | | | μА |
| $(0.5 \le V_{I(S/R)} \le 2.7 \text{ V})$ | 1(S/R) | -100 | _ | 20 | |
| $(V_{I(S/R)} = 5.5 \text{ V})$ | IB(S/R) | _ | _ | 100 | |
| Input Current — Enable | 10(3/11/ | | | | μΑ |
| $(0.5 \le V_{I(E)} \le 2.7 \text{ V})$ | II(E) | -200 | _ | 20 | |
| $(V_{I(E)} = 5.5 \text{ V})$ | IB(E) | _ | _ | 100 | l |
| Driver Input Clamp Voltage | VIC(D) | | | -1.5 | V |
| (V _I (S/R) = 2.0 V, I _I C(D) = -18 mA) | VIC(D) | _ | _ | -1.5 | , |
| Driver Output Voltage — High Logic State | | 2.5 | <u> </u> | | V |
| (V _I (S/R) = 2.0 V, V _I H(D) = 2.0 V, V _I H(E) = 2.0 V, I _{OH} = -5.2 mA) | VOH(D) | 2.5 | - | _ | ľ |
| | | | ļ | 0.5 | - v |
| Driver Output Voltage – Low Logic State (Note 1) | VOL(D) | - | _ | 0.5 | ľ |
| $(V_{I(S/R)} = 2.0 \text{ V, } I_{OL(D)} = 48 \text{ mA})$ | | | | 400 | |
| Output Short Circuit Current | OS(D) | -30 | _ | -120 | mA |
| $(V_{I(S/R)} = 2.0 \text{ V}, V_{IH(D)} = 2.0 \text{ V}, V_{IH(E)} = 2.0 \text{ V})$ | | | | | L |
| Power Supply Current | | | | | mA |
| (Listening Mode – All Receivers On) | ICCL | - | 63 | 85 | 1 |
| (Talking Mode - All Drivers On) | Іссн | | 106 | 125 | |

SWITCHING CHARACTERISTICS (V_{CC} = 5.0 V, T_A = 25°C unless otherwise noted)

| Propagation Delay of Driver | | | | | ns | ı |
|-------------------------------|---------------------|-----|---|----|----|---|
| (Output Low to High) | tPLH(D) | - 1 | - | 15 | 1 | l |
| (Output High to Low) | ^t PHL(D) | - | - | 17 | 1 | |
| Propagation Delay of Receiver | | | | | ns | |
| (Output Low to High) | tPLH(R) | - | - | 25 | j | ı |
| (Output High to Low) | tPHL(R) | _ | | 23 | 1 | |

NOTE 1. A modification of the IEEE 488-1978 Bus Standard changes VOL(D) from 0.4 to 0.5 V maximum to permit the use of Schottky technology.

SWITCHING CHARACTERISTICS (continued) ($V_{CC} = 5.0 \text{ V}$, $T_A = 25^{\circ}\text{C}$ unless otherwise noted)

| Characteristic | Symbol | Min | Тур | Max | Unit |
|---|----------|-----|-----|-----|------|
| Propagation Delay Time - Send/Receive to Data | | | | 1 | ns |
| Logic High to Third State | tPHZ(R) | - | - | 30 | |
| Third State to Logic High | tPZH(R) | - | _ | 30 | |
| Logic Low to Third State | tPLZ(R) | - | - | 30 | |
| Third State to Logic Low | tPZL(R) | - | - | 30 | |
| Propagation Delay Time — Send/Receive to Bus | | | | | ns |
| Logic High to Third State | tPHZ(D) | l – | _ | 30 | |
| Third State to Logic High | tPZH(D) | ١ – | i – | 30 | |
| Logic Low to Third State | tPLZ(D) | - | - | 30 | |
| Third State to Logic Low | tPZL(D) | | _ | 30 | |
| Turn-On Time — Enable to Bus | | | | | ns |
| Pull-Up Enable to Open Collector | tPOFF(E) | _ | - | 30 | |
| Open Collector to Pull-Up Enable | tPON(E) | | - | 20 | |

PROPAGATION DELAY TEST CIRCUITS AND WAVEFORMS

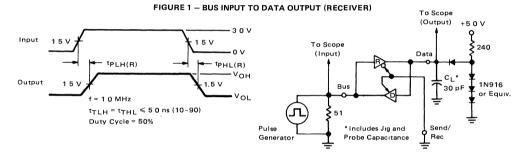
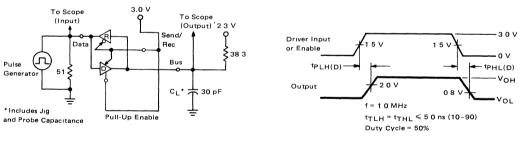


FIGURE 2 - DATA INPUT TO BUS OUTPUT (DRIVER)



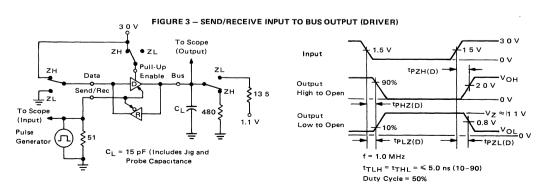
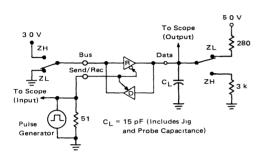


FIGURE 4 - SEND/RECEIVE INPUT TO DATA OUTPUT (RECEIVER)



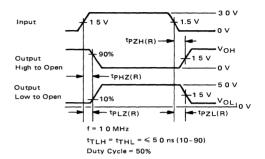
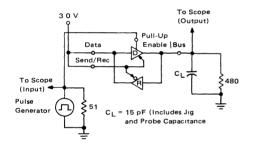
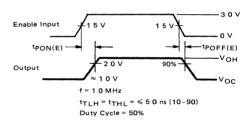
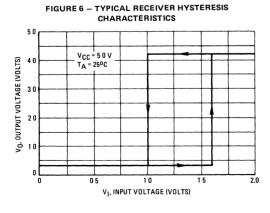


FIGURE 5 - ENABLE INPUT TO BUS OUTPUT (DRIVER)







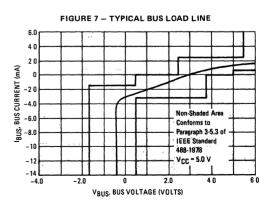
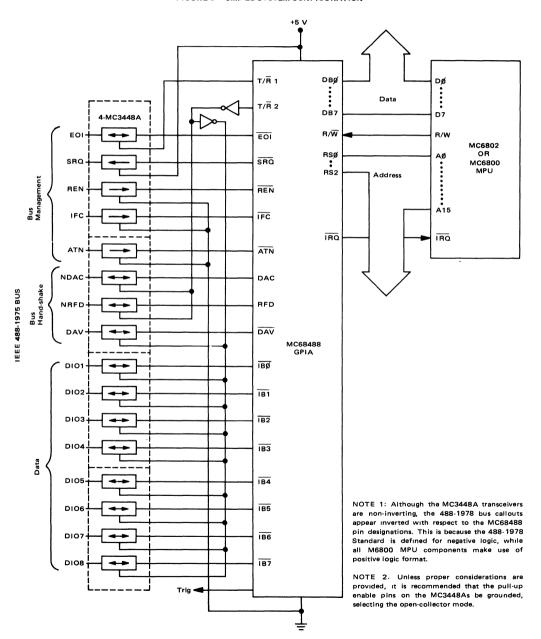
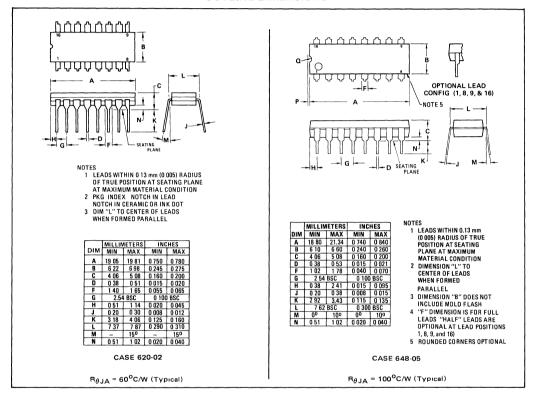


FIGURE 8 - SIMPLE SYSTEM CONFIGURATION



OUTLINE DIMENSIONS



THERMAL INFORMATION

The maximum power consumption an integrated circuit can tolerate at a given operating ambient temperature, can be found from the equation:

$$P_{D(T_A)} = \frac{T_{J(max)} - T_A}{R_{\theta JA}(T_{yp})}$$

Where: $P_{D(T_A)}$ = Power Dissipation allowable at a given operating ambient temperature. This must be greater than

the sum of the products of the supply voltages and supply currents at the worst case operating condition.

T_{J(max)} = Maximum Operating Junction Temperature as listed in the Maximum Ratings Section

TA = Maximum Desired Operating Ambient

Temperature

 $R_{\theta JA}(Typ) = Typical Thermal Resistance Junction to Ambient$



OCTAL THREE-STATE BUFFER/LATCH

This series of devices combines four features usually found desirable in bus-oriented systems: 1) High impedance logic inputs insure that these devices do not seriously load the bus; 2) Three-state logic configuration allows buffers not being utilized to be effectively removed from the bus; 3) Schottky technology allows for high-speed operation; 4) 48 mA drive capability.

- Inverting and Non-Inverting Options of Data
- SN74S373 Function Pinouts
- Eight Transparent Latches/Buffers in a Single Package
- Full Parallel-Access for Loading and Reloading
- Buffered Control Inputs
- All Inputs Have Hysteresis to Improve Noise Rejection
- High Speed − 8.0 ns (Typ)
- Three-State Logic Configuration
- Single +5 V Power Supply Requirement
- Compatible with 74S Logic or M6800 Microprocessor Systems
- High Impedance PNP Inputs Assure Minimal Loading of the Bus

MICROPROCESSOR BUS EXTENDER APPLICATION (Clock) Gnd +5 V M6800 MPU MC3482A/MC6882A MC6880A/MC8T26A MC3482B/MC6882B Bus Extender Buffer/Latch MC6830 Address and Data Control Bus MC6810 RAMs MC6820 PIAs MC6850 ACIAs MC6860 To DAA

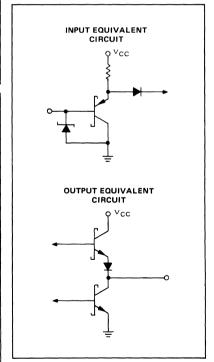
MC3482A/MC6882A MC3482B/MC6882B

This device may be ordered under either of the above type numbers.

OCTAL THREE-STATE BUFFER/LATCH



L SUFFIX CASE 732



ORDERING INFORMATION

(Temperature Range for the following devices = $0 \text{ to } +75^{\circ}\text{C}$)

| Device | Alternate | Package |
|----------|-----------|-------------|
| MC3482AL | MC6882AL | Ceramic DIP |
| MC3482BL | MC6882BL | Ceramic DIP |

MAXIMUM RATINGS (TA = 25°C unless otherwise noted.)

| Rating | Symbol | Value | Unit |
|-------------------------------------|------------------|-------------|------|
| Power Supply Voltage | Vcc | 8.0 | Vdc |
| Input Voltage | VI | 5.5 | Vdc |
| Operating Ambient Temperature Range | TA | 0 to +75 | οс |
| Storage Temperature Range | T _{stg} | -65 to +150 | °C |
| Operating Junction Temperature | Tj | | °C |
| Ceramic Package | | 175 | |

ELECTRICAL CHARACTERISTICS (Unless otherwise noted, 0° C \leq T_A \leq 75 $^{\circ}$ C and 4.75 V \leq V_{CC} \leq 5.25 V)

| Characteristic | Symbol | Min | Тур | Max | Unit |
|---|--------|--------|--------|-------------|----------|
| Input Voltage — High Logic State (V _{CC} = 4.75 V, T _A = 25°C) | ViH | 2.0 | - | - | V |
| Input Voltage — Low Logic State (V _{CC} = 4.75 V, T _A = 25°C) | VIL | - | _ | 0.8 | ٧ |
| Input Current — High Logic State (V _{CC} = 5.25 V, V _{IH} = 2.4 V) | ЧН | - | **** | 40 | μА |
| Input Current — Low Logic State (V _{CC} = 5.25 V, V _{IL} = 0.5 V, V _{IL} (OE) = 0.5 V) | IIL | | _ | -250 | μΑ |
| Output Voltage - High Logic State (V _{CC} = 4.75 V, I _{OH} = -20 mA) | Voн | 2.4 | _ | - | ٧ |
| Output Voltage — Low Logic State (IOL = 48 mA) | VOL | _ | - | 0.5 | ٧ |
| Output Current — High Impedance State (V_{CC} = 5.25 V, V_{OH} = 2.4 V) (V_{CC} = 5.25 V, V_{OL} = 0.5 V) | loz | _ _ | _ _ | 100 –100 | μА |
| Output Short-Circuit Current ($V_{CC} = 5.25 \text{ V}$, $V_{O} = 0$) (only one output can be shorted at a time) | los | -30 | -80 | -130 | mA |
| Power Supply Current MC3482A/MC6882A (V _{CC} = 5.25 V) MC3482B/MC6882B | ¹cc | | | 130 150 | mA |
| Input Clamp Voltage (V _{CC} = 4.75 V, I _{I K} = -12 mA) | VIK | - | - | -1.2 | ٧ |

$\textbf{SWITCHING CHARACTERISTICS} \ \, (\text{V}_{CC} = 5 \ \text{O} \ \text{V}, \, \text{0}^{\circ}\text{C} \leqslant \text{T}_{A} \leqslant +75^{\circ}\text{C}, \, \text{unless otherwise noted, typical @ T}_{A} = 25^{\circ}\text{C} \, \,)$

| Characteristics | Symbol | MC3482A/ MC6882A | | | MC3482B/ MC6882B | | | Unit |
|-------------------------------------|---------------------|---------------------|-----|----------|---------------------|------|-----|------|
| | | Min | Тур | Max | Min | Тур | Max | |
| Propagation Delay Times | | | | | | | | ns |
| Data to Output | | | | | | | | |
| Low to High | tPLH(D) | İ | | | | | | |
| C _L = 50 pF | | 40 | 90 | 16 | 40 | 90 | 16 | |
| C _L = 250 pF | | - | 12 | 20 | - | 12 | 20 | |
| C _L = 375 pF | | - | 14 | 22 | - | 14 | 22 | |
| C _L = 500 pF | | 10 | 16 | 24 | 10 | 16 | 24 | |
| High to Low | tPHL(D) | 1 | | | | | | |
| CL = 50 pF | | 4.0 | 8.0 | 16 | 40 | 8.0 | 16 | |
| C _L = 250 pF | | - | 15 | 22 | - | 15 | 22 | |
| C _L = 375 pF | | | 18 | 25 | | 17 | 24 | |
| C _L = 500 pF | | 16 | 21 | 28 | 14 | 18 | 27 | |
| Propagation Delay Times | | | | | | | | ns |
| Latch Disable (Low to High) | | | l | } | | | | |
| to Output | | | l | | | | | |
| Low to High | ^t PLH(L) | | | 1 | | | | |
| C _L = 50 pF | | - | 22 | 30 | - | 18 ′ | 30 | |
| High to Low | tPHL(L) | | | | | | | |
| C _L = 50 pF | , | - | 23 | 30 | _ | 14 | 25 | |
| Propagation Delay Times | | | | | | | | ns |
| (C _L = 20 pF) | | 1 | l | 1 | | | | |
| High Output Level to High Impedance | tPHZ(OE) | - | 8.0 | 15 | _ | 6.0 | 13 | |
| Low Output to High Impedance | tPLZ(OE) | - | 20 | 27 | - | 15 | 23 | |
| High Impedance to High Output | tPZH(OE) | - | 9.0 | 16 | _ | 11 | 18 | |
| High Impedance to Low Output | tPZL(OE) | - | 13 | 20 | _ | 9.0 | 16 | |

AC SETUP CHARACTERISTICS (V_{CC} = 5.0 V, 0°C \leq T_A \leq +75°C, unless otherwise noted, typical @ T_A = 25°C.)

| Characteristic | Symbol | MC3482A/ MC6882A | | | MC3482B/ MC6882B | | | Unit |
|---|--------------------|---------------------|-----|-----|---------------------|-----|-----|------|
| | | Min | Тур | Max | Min | Тур | Max | |
| Setup Time (Data to Negative Going Latch Enable) | t _{su(D)} | 10 | 0 | - | 7.0 | 0 | - | ns |
| Hold Time (Data to Negative Going Latch Enable) | th(D) | 10 | - | - | 8.0 | - | - | ns |
| Minimum Latch Enable Pulse Width (High or Low) | tW(L) | - | 15 | - | - | 15 | - | ns |

PIN CONNECTIONS AND TRUTH TABLES

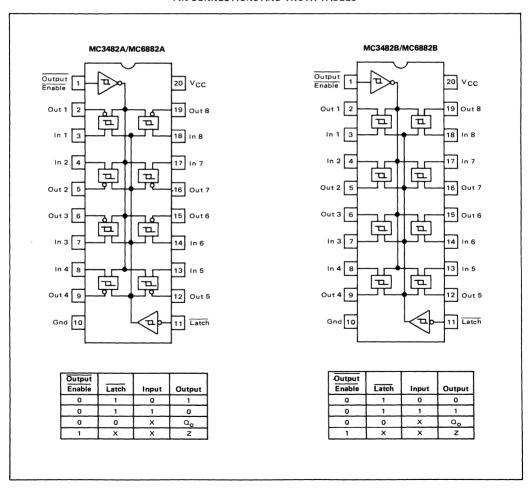


FIGURE 2 - WAVEFORMS FOR PROPAGATION DELAY FIGURE 1 - TEST CIRCUIT FOR SWITCHING CHARACTERISTICS TIMES DATA TO OUTPUT - 3 V To Scope To Scope (Input) Output 1 5 V Closed for - o v Input or tPLZ(OE), tPZL(OE) only Input -tPLH(D) Enable ^tPHL(D)→ +5 V - v_{oh} Output 1 5 V MC3482A/MC6882A 50 ≂c_L 1N3064 · VOL Pulse or Equivalent tpLH(D)-← tPHL(D) Generato Vон Output 1 5 V MC3482B/MC6882B VOL 10 k Closed for C_L Includes Probe and tPHZ(OE),tPZH(OE) only Input Pulse Conditions t_{THL} = t_{TLH} < 5 ns f = 1 0 MHz Jig Capacitance

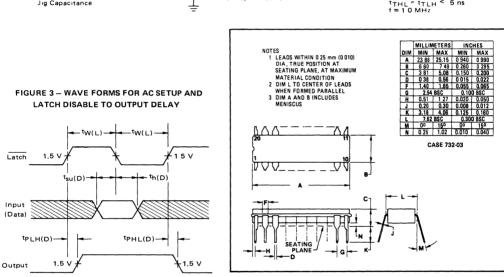
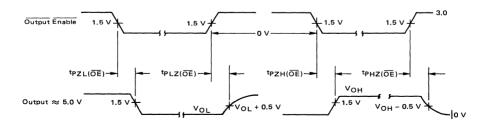


FIGURE 4 – WAVEFORMS FOR PROPAGATION DELAY
TIMES – OUTPUT ENABLE TO OUTPUT





MC3870

Advance Information

SINGLE-CHIP MICROCONTROLLER

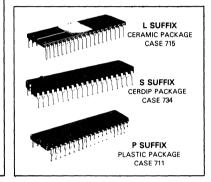
The MC3870 is a monolithic 8-bit microcomputer utilizing ion-implanted, N-channel silicon-gate technology and advanced circuit design techniques. The single-chip 3870 offers maximum cost effectiveness in a wide range of control and logic replacement applications.

- Software Compatible with F8 Family
- 2048 Byte Mask Programmable ROM
- 64 Byte Scratchpad RAM
- 32 Bits (4 Ports) TTL-Compatible I/O
- Programmable Binary Timer Interval Timer Mode
 Pulse Width Measurement Mode
 Event Counter Mode
- External Interrupt
- Crystal, LC, RC, External
- Low Power (275 mW Typ)
- Single +5 Volt ± 10% Power Supply

MOS

(N-CHANNEL, SILICON-GATE DEPLETION LOAD)

SINGLE-CHIP MICROCONTROLLER

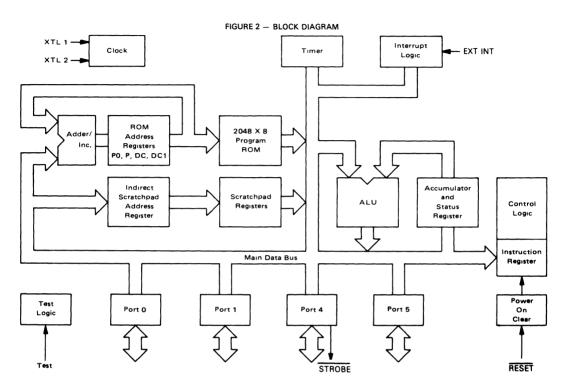


ABSOLUTE MAXIMUM RATINGS*

| Operating T | emperature |
|---------------------|---|
| 0 to 70°C | - 40 to +85°C |
| -20°C to +85°C | -50°C to +100°C |
| -65°C to +150°C | -65°C to +150°C |
| -10 V to +7 V | -10 V to +7 V |
| -10 V to +9 V | -10 V to +9 V |
| - 1 0 V to + 13 5 V | -10 V to +135 V |
| 1 5 W | 1 5 W |
| 60 mW | 60 mW |
| 600 mW | 600 mW |
| | 0 to 70°C -20°C to +85°C -65°C to +150°C -10 V to +7 V -10 V to +9 V -10 V to +13 5 V 15 W 60 mW |

*Stresses above those listed under "Absolute Maximurn Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

| FIGURE 1 — PIN ASSIGNMENT | | | | | |
|---------------------------|-----------------------------|--|--|--|--|
| | | | | | |
| XTL 1€ 1 ● | 40 1 VCC | | | | |
| XTL 2 0 2 | 39 RESET | | | | |
| PO-0 D 3 | 38 EXT INT | | | | |
| PO-1 C 4 | 37 p P1-0 | | | | |
| PO-2 C 5 | 36 7 P1-1 | | | | |
| PO-3 C 6 | 35 7 P1-2 | | | | |
| STROBE 7 | 34 🕽 PT-3 | | | | |
| P4-0 □ 8 | 33 1 P5-0 | | | | |
| P4-1 0 9 | 32 7 P5-1 | | | | |
| P4-2 [10 | 31 🗖 P5-2 | | | | |
| P4-3 C 11 | 30 7 P5-3 | | | | |
| P4-4 [12 | 29 1 P5-4 | | | | |
| P4-5 [13 | 28 🗖 P5-5 | | | | |
| P4-6 □ 14 | 27 🏻 P5-6 | | | | |
| P4-7 [15 | 26 🗖 P5-7 | | | | |
| PO-7 C 16 | 25 🗖 P1-7 | | | | |
| PO-6 C 17 | 24 🗖 P1-6 | | | | |
| PO-5 [18 | 23 1 P1-5 | | | | |
| PO-4 [19 | 22 P1-4 | | | | |
| GND [20 | 21 🕽 TEST | | | | |
| | | | | | |



AC CHARACTERISTICS

| Signal | Cumbal | Parameter | 0 to 70°C | | -40° to + | 85°C | Unit | Notes | |
|--------------|--------------------|--|-------------------------------------|---------------|--|-----------------|-------|--------------------------------------|--|
| Signal | Symbol | rarameter | Min | Max | Min | Max | Offic | IVOLES | |
| XTL1 XTL2 | to | Time Base Period, all clock modes | 250 | 1000 | 250 | 500 | ns | | |
| | tex(H) | External clock pulse width high | 90 | 700 | 100 | 390 | ns | | |
| | tex(L) | External clock pulse width low | 100 | 700 | 110 | 390 | ns | | |
| φ | tφ | Internal ϕ clock | 2t ₀ | | | 2t ₀ | | | |
| WRITE | tw | Internal WRITE Clock period | 4tφ 6tφ | | | 4tφ 6tφ | | Short Cycle Long Cycle | |
| 1/0 | tdl/O | Output delay from internal WRITE clock | 0 | 1000 | 0 | 1200 | ns | 50 pF plus one TTL load | |
| | tsI/O | Input setup time to internal WRITE clock | 1000 | | 1200 | | ns | | |
| STROBE | t _{I/O-s} | Output valid to STROBE delay | 3tφ - 1000 | 3tø + 250 | 3tφ - 1200 | 3tø + 300 | ns | I/O load = 50 pF + 1 TTL load | |
| SIROBE | t _{SL} | STROBE low time | 8tφ 250 | 12tφ + 250 | 8tφ 300 | 12tφ + 300 | ns | STROBE load = 50 pF + 3 TTL loads | |
| | ^t RH | RESET hold time, low | 6tø + 750 | | 6tφ + 1000 | | ns | | |
| RESET | ^t RPOC | RESET hold time, low for power clear | power supply rise time +01 | | power supply rise time + 0 15 | | ms | | |
| EXT INT | ^t EH | EXT INT hold time in active and inactive state | 6tø + 750 | | 6tφ + 1000 | | ns | To trigger interrupt | |
| | | | 2tφ | | 2tφ | | ns | To trigger timer | |

DC CHARACTERISTICS (I/O Power Dissipation ≤ 100 mW) (Note 2)

| Sbal | Symbol Parameter | | 0 to 70 + C | | -40 to +85°C | | Conditions |
|---------------------|---|-------|-------------|-------|--------------|------|-------------------------------------|
| Symbol | rarameter | Min | Max | Min | Max | Unit | Conditions |
| Vcc | Power Supply Voltage | 4 5 | 5 5 | 4 75 | 5 25 | ٧ | |
| VIHEX | External Clock Input High Level | 2 4 | Vcc | 2 4 | Vcc | ٧ | |
| VILEX | External Clock Input Low Level | -03 | 0 6 | -03 | 06 | ٧ | |
| IHEX | External Clock Input High Current | _ | 100 | _ | 130 | μΑ | VIHEX = VCC |
| ILEX | External Clock Input Low Current | _ | - 100 | _ | - 130 | μА | V _{ILEX} = V _{SS} |
| V | Input High Level, I/O Pins | 20 | Vcc | 2 2 | Vcc | V | Standard Pullup |
| V _{IHI} /O | input high Level, I/O Fins | 20 | 13 2 | 22 | 13 2 | V | Open Drain (1) |
| v_{IHR} | Input High Level, RESET | 20 | Vcc | 2 2 | Vcc | ٧ | |
| VIHEI | Input High Level, EXT INT | 20 | VCC | 22 | VCC | | |
| VIL | Input Low Level | -03 | 0 8 | -03 | 07 | ٧ | (1) |
| IL | Input Low Current, All Pins with Standard Pullup Resistor | _ | -16 | _ | -19 | mΑ | V _{IN} = 0 4 V |
| 1. | Input Leakage Current, Open Drain Pins, | | + 10 | _ | + 18 | μА | V _{IN} = 13 2 V |
| ال | and Inputs with No Pullup Resistor | | -5 | | -8 | μΑ | $V_{IN} = 0.2 V$ |
| ЮН | Output High Current Pins with Standard Pullup Resistor | - 100 | _ | - 90 | _ | μΑ | V _{OH} = 2 4 V |
| loupp | Output High Current Direct Drive Pins | -15 | _ | -13 | _ | mΑ | V _{OH} =15 V |
| lohdd | Output High Culterit Direct Drive Firis | | -85 | | - 11 | | V _{OH} =07 V |
| lons | STROBE Output High Current | - 300 | | - 270 | _ | μΑ | $V_{OL} = 24 V$ |
| loL | Output Low Current | 18 | | 1 65 | _ | mΑ | V _{OL} = 0 4 V |
| lols | STROBE Output Low Current | 50 | | 4 5 | - | mΑ | V _{OL} =04 V |
| Icc | Power Supply Current | | 85 | | 110 | mA | Outputs Open |
| PD | Power Dissipation | - | 400 | _ | 525 | mW | Outputs Open |
| | | | | | | | |

¹ RESET and EXT INT have internal Schmitt triggers giving minimum 0.2 V hysteresis

TIMER AC CHARACTERISTICS

Definitions

Error = Indicated time value - actual time value

 $t_{DSC} = t\phi \times Prescale Value$

Interval Timer Mode:

Single interval error, free running (Note 3)
Cumulative interval error free running (Note 3)
Error between two Timer reads (Note 2)
Start Timer to stop Timer error (Notes 1, 4)
Start Timer to read Timer error (Notes 1, 2)
Start Timer to interrupt request error (Notes 1, 3)
Load Timer to Stop Timer error (Note 1)
Load Timer to interrupt request error (Notes 1, 2)

 $\begin{array}{c} \pm 6 \mathrm{i} \phi \\ 0 \\ \pm (\mathrm{tpsc} + \mathrm{t} \phi) \\ + \mathrm{t} \phi \mathrm{to} - (\mathrm{tpsc} + \mathrm{t} \phi) \\ - 5 \mathrm{t} \phi \mathrm{\ to} - (\mathrm{tpsc} + 7 \mathrm{t} \phi) \\ - 2 \mathrm{t} \phi \mathrm{\ to} - 8 \mathrm{t} \phi \\ + \mathrm{t} \phi \mathrm{\ to} - (\mathrm{tpsc} + 2 \mathrm{t} \phi) \\ - 5 \mathrm{t} \pm \mathrm{to} - (\mathrm{tpsc} + 8 \mathrm{t} \phi) \\ - 2 \mathrm{t} \phi \mathrm{\ to} - 9 \mathrm{t} \phi \end{array}$

Pulse Width Measurement Mode:

Measurement accuracy (Note 4)
Minimum pulse width of EXT INT pin

+ $t\phi$ to - $(t_{psc} + 2t\phi)$

Event Counter Mode:

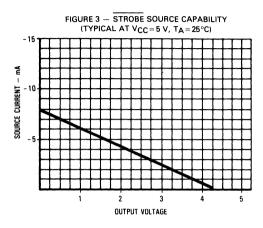
Minimum active time of EXT INT pin Minimum inactive time of EXT INT pin

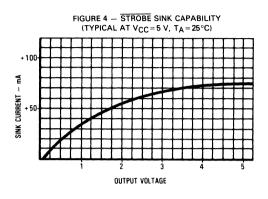
2tφ 2tφ

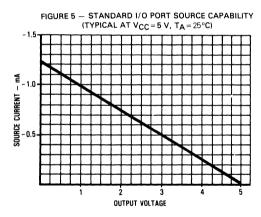
NOTES

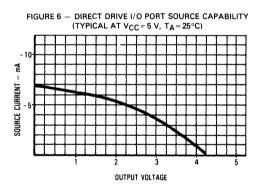
- 1 All times which entail loading, starting, or stopping the Timer are referenced from the end of the last machine cycle of the OUT or OUTS instruction
- 2 All times which entail reading the Timer are referenced from the end of the last machine cycle of the IN or INS instruction
- 3 All times which entail the generation of an interrupt request are referenced from the start of the machine cycle in which the appropriate interrupt request latch is set. Additional time may elapse if the interrupt request occurs during a privileged or multicycle instruction.
- 4 Error may be cumulative if operation is repetitively performed

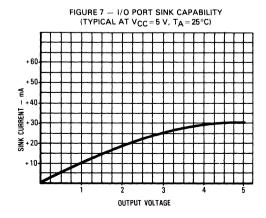
² Power dissipation for I/O pins is calculated by $\Sigma(V_{CC} - V_{IL})$ ($|I_{IL}|$) = $\Sigma(V_{CC} - V_{OH})(|I_{OH}|) = \Sigma(V_{OL})(|I_{OL}|)$











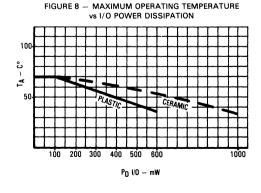


FIGURE 9 - MC3870 IDD vs TEMPERATURE (V_{CC}=5 V)

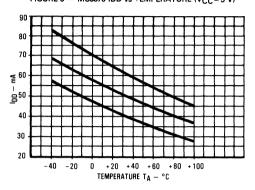
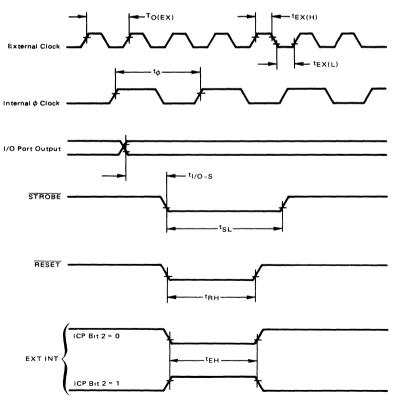
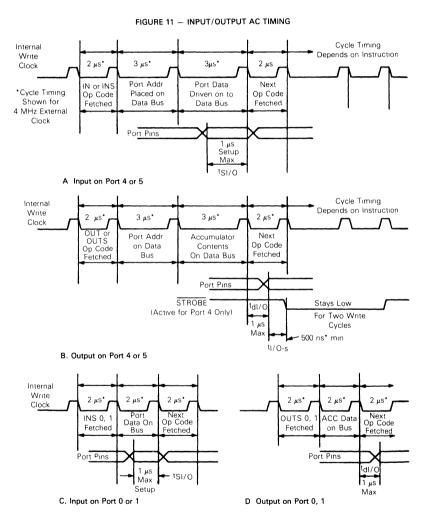


FIGURE 10 — AC TIMING DIAGRAM



NOTE $\,$ All measurements are referenced to V $_{IL}$ max , V $_{IH}$ min , V $_{OL}$ max , or V $_{OH}$ min



3870 CLOCKS

The time base for the 3870 may originate from one of four sources The four configurations are shown in Figure 12 There is an internal 26 pF capacitor between XTL 1 and GND and an internal 26 pF capacitor between XTL 2 and GND Thus, external capacitors are not necessarily required. In all external clock modes the external time-base frequency is divided by two to form the internal ϕ clock. The external clock frequency is divided by eight during short instruction cycles and is divided by twelve during long instruction cycles as given per instruction in the instruction set towards the end of this data sheet. To get the total instruction cycle time, divide the external clock frequency by eight, invert the number, then multiply by the short number of cycles Then divide the external clock frequency by twelve and invert the number (Yx) then multiply by the number of long cycles Add these two numbers to get the number of nanoseconds per instruction for a given clock frequency

CRYSTAL SELECTION

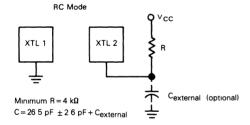
The use of a crystal as the time base is highly recommended as the frequency stability and reproducability from

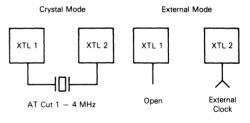
system-to-system is unsurpassed. The 3870 has an internal divide-by-two to allow the use of inexpensive and widely available TV Color Burst Crystals (3 58 MHz). The following crystal parameters are suggested for 3870 applications.

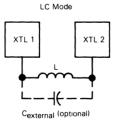
- a) Parallel Resonance, Fundamental Mode AT-Cut, $HC-33/\mu$ holder
- b) Frequency Tolerance measured with 18 pF load (0.1% accuracy) drive level 10 mW
- c) Shunt capacitance (Co) = 7 pF max
- d) Series resistance (Rs)

| f=1 MHz | Rs = 550 ohms max |
|--------------|-------------------|
| f=2 MHz | Rs = 300 ohms max |
| f=3 MHz | Rs = 100 ohms max |
| f = 3 58 MHz | Rs = 100 ohms max |
| f=4 MHz | Rs = 100 ohms max |

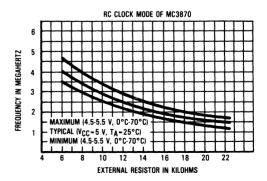
FIGURE 12 - CLOCK CONFIGURATION







Minimum L=0 1 mH Minimum Q=40 Maximum $C_{external} = 30 pF$ $C = 13 pF \pm 1 3 pF + C_{external}$



FUNCTIONAL PIN DESCRIPTION

P0-0 - P0-7 AND P1-0 - P1-7

Ports 1 and 2 are 16 lines which can be individually used as standard TTL-type inputs or latched outputs

P4-0 - P4-7 AND P5-0 - P5-7

Ports 4 and 5 are 16 lines which can be individually used as standard, open drain, or direct drive type latched outputs or inputs. Refer to Figure 15 for more information on port options.

STROBE

This output, which is normally high, provides a single low pulse after valid data is present on port 4 ($\overline{P4-0}$ - $\overline{P4-7}$) during an output instruction

RESET

This active low input is used to reset the internal state of the microcomputer. When allowed to go high, program execution begins at \$000

EXT/INT

This input is an external interrupt. Its active state is soft-ware programmable. The input is also used in conjunction with the timer for pulse width measurement and event counting.

XTL 1 AND XTL 2

These two inputs interface a crystal (1 to 4 MHz), LC network, RC network, or an external single-phase clock to the microcomputer

TEST

TEST is an input used only in testing the MC3870. For normal circuit functionality, this pin is left unconnected or may be grounded.

Vcc

This is the power supply input ($\pm 5 \text{ V } \pm 10\%$)

| Pin Name | Description | Type |
|-----------------------|--------------------|---------------|
| P0-0 - P0-7 | I/O Port 0 | Bidirectional |
| P1-0 - P1-7 | I/O Port 1 | Bidirectional |
| P4-0 P4-7 | I/O Port 4 | Bidirectional |
| P5-0 - P5-7 | I/O Port 5 | Bidirectional |
| STROBE | Ready Strobe | Output |
| EXT INT | External Interrupt | Input |
| RESET | External Reset | Input |
| TEST | Test Line | Input |
| XTL 1, XTL 2 | Time Base | Input |
| V _{CC} , GND | Power Supply Lines | Input |

3870 ARCHITECTURE

This section describes the basic functional elements of the 3870 as shown in the block diagram of Figure 2. A programming model is shown in Figure 13.

MAIN CONTROL LOGIC

The Instruction Register (IR) receives the operation code (OP code) or the instruction to be executed from the program ROM via the data bus. During all OP code fetches eight bits are latched into the IR. Some instructions are completely specified by the upper four bits of the OP code. In those instructions the lower four bits are an immediate register address or an immediate 4-bit operand. Once latched into the IR the main control logic decodes the instruction and provides the necessary control gating signals to all circuit elements.

ROM ADDRESS REGISTERS

There are four 11-bit registers associated with the $2K \times 8$ ROM. These are the Program Counter (PD), the Stack Register (PI), the Data Counter (DC), and the Auxiliary Data Counter (DC1). The Program Counter is used to address instructions or immediate operands. P is used to save the contents of PO during an interrupt or subroutine call. Thus, P contains the return address at which processing is to resume upon completion of the subroutine or the interrupt routine.

The Data Counter (DC) is used to address data tables. This register is auto-incrementing. Of the two data counters only DC can access the ROM. However, the XDC instruction allows DC and DC1 to be exchanged.

Associated with the address registers is an 11-bit Adder/Incrementer. This logic element is used to increment P0 or DC when required an i is also used to add displacements to P0 on relative branches or to add the data bus contents to DC in the ADC (Add Data Counter) instruction.

2048 × 8 ROM

The microcomputer program and data constants are stored in the program ROM. When a ROM access is required, the appropriate address register (P0 or DC) is gated onto the ROM address bus and the ROM output is gated onto the main data bus. The first byte in the ROM is location zero.

SCRATCHPAD AND IS

The scratchpad provides 64 8-bit registers which may be used as general purpose RAM memory. The Indirect Scratchpad Address Register (IS) is a 6-bit register used to address the 64 registers. All 64 registers may be accessed using IS. In addition, the lower order 12 registers may also be directly addressed.

IS can be visualized as holding two octal digits. This division of IS is important since a number of instructions increment or decrement only the least-significant three bits of IS when referencing scratchpad bytes via IS. This makes it easy to reference a buffer consisting of contiguous scratchpad bytes. For example, when the low order octal digit is incremented or decremented IS is incremented from octal 27 (0'28') to 0'20') or is decremented from 0'20' to 0'27'. This feature of the IS is very useful in many program sequences. All six bits of IS may be loaded at one time or either half may be loaded independently.

Scratchpad registers 9 through 15 (decimal) are given mnemonic names (J, H, K, and Q) because of special linkages between these registers and other registers such as

the Stack Register These special linkages facilitate the implementation of multi-level interrupts and subroutine nesting For example, the instruction LR K,P stores the lower eight bits of the Stack Register into register 13 (K lower or KL) and stores the upper three bits of P into register 12 (K upper or KU)

ARITHMETIC AND LOGIC UNIT (ALU)

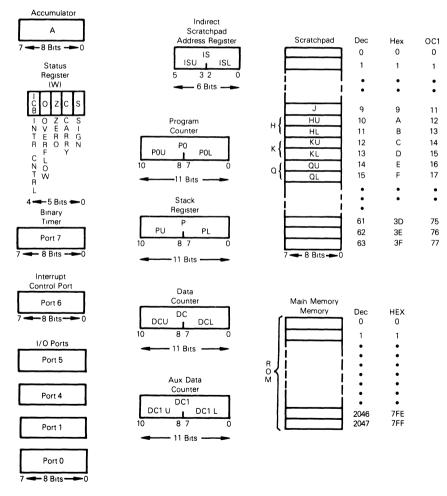
After receiving commands from the main control logic, the ALU performs the required arithmetic or logic operations (using the data presented on the two input buses) and produces the result on the result bus. The arithmetic operations that can be performed in the ALU are binary add, decimal ad-

just, add with carry, decrement, and increment The logic operations that can be performed are AND, OR, EXCLUSIVE OR, "1's" complement, shift right, and shift left Besides providing the result on the result bus, the ALU also provides four signals representing the status of the result These signals, stored in the Status Register (W), represent CARRY, OVERFLOW, SIGN, and ZERO condition of the result of the operation

ACCUMULATOR (A)

The Accumulator (A) is the principal register for data manipulation within the 3870. The A serves as one input to the ALU for arithmetic or logical operations. The result of ALU operations are stored in the A.

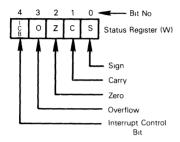
FIGURE 13 - MC3870 PROGRAMMABLE REGISTERS, PORTS, AND MEMORY MAP



THE STATUS REGISTER (W)

The Status Register (also called the W register) holds five status flags as shown in Figure 14

FIGURE 14 - STATUS REGISTER (W)



Summary of Status Bits

OVERFLOW = Carry₇ Φ CARRY₆

ZERO = ALU₇ΛALU₆ΛALU₅ΛALU₄ΛALU₃ΛALU₂Λ

ALU₁ΛALU₆CARRY = CARRY₇

SIGN = ALU7

INTERRUPT CONTROL BIT (ICB)

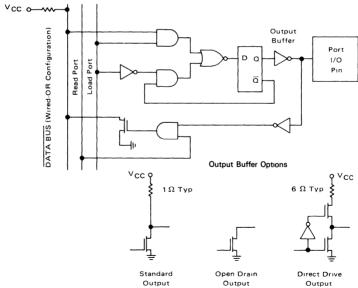
The ICB may be used to allow or disallow interrupts in the MC3870. This bit is not the same as the two interrupt enable bits in the Interrupt Control Port (ICP). If the ICB is set and the MC3870 interrupt logic communicates an interrupt request to the CPU section, the interrupt will be acknowledged and processed upon completion of the first non-privileged instruction. If the ICB is cleared an interrupt request will not be acknowledged or processed until the ICB is set.

I/O PORTS

The MC3870 provides four complete bidirectional Input/Output ports. These are ports 0, 1, 4, and 5. In addition, the Interrupt Control Port is addressed as port 6 and the binary timer is addressed as port 7. An output instruction (OUT or OUTS) causes the contents of A to be latched into the addressed port. An input instruction (IN or INS) transfers the contents of the port to A (port 6 is an exception which is described later). The schematic of an I/O pin and available output drive options are shown in Figure 15.

An output ready strobe is associated with port 4. This flag may be used to signal a peripheral device that the MC3870 has just completed an output of new data to port 4. The strobe provides a single low pulse shortly after the output operation is completely finished, so either edge may be used to signal the peripheral \$\overline{STROBE}\$ may also be used as an input strobe simply by doing a dummy output of H '00' strobe to port 4 after completing the input operation

FIGURE 15 - I/O PIN CONCEPTUAL DIAGRAM WITH OUTPUT BUFFER OPTIONS



Ports 0 and 1 are Standard Output type only

Ports 4 and 5 may both be any of the three output options (programmable bit-by-bit)

The $\overline{\text{STROBE}}$ output is always configured similar to a Direct Drive Output except that it is capable of driving 3 TTL loads $\overline{\text{RESET}}$ and EXT INT may have standard 6 k Ω (typical) pullup or may have no pullup. These two inputs have Schmitt trigger inputs with a minimum of 0.2 volts of hysteresis

TIMER AND INTERRUPT CONTROL PORT

The Timer is an 8-bit binary down counter which is software programmable to operate in one of three modes the Interval Timer Mode, the Pulse Width Measurement Mode, or the Event Counter Mode As shown in Figure 16, associated with the Timer are an 8-bit register called the interurpt control port, a programmable prescaler, and an 8-bit modulo-N register. A functional logic diagram is shown in Figure 17.

INTERRUPT CONTROL PORT (PORT 6)

The desired timer mode, prescale value, starting and stopping the timer, active level of the EXT INT pin, and local enabling or disabling of interrupts are selected by outputting the proper bit configuration from the Accumulator to the Interrupt Control Port (port 6) with an OUT or OUTS instruction Bits within the Interrupt Control Port are defined as follows

Bit 0 - External Interrupt Enable

Bit 1 - Timer Interrupt Enable

Bit 2 - EXT INT Active Level

Bit 3 - Start/Stop Timer

Bit 4 - Pulse Width/Interval Timer

Bit 5 -- - 2 Prescale

Bit 6 - - 5 Prescale

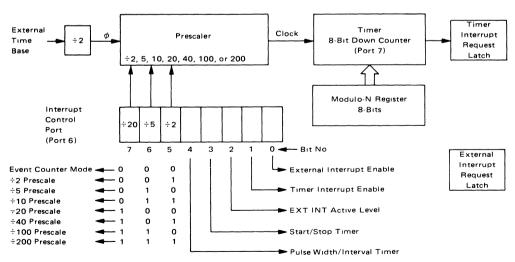
Bit 7 - - 20 Prescale

A special situation exists when reading the Interrupt Control Port (with IN or INS instruction) The Accumulator is not loaded with the content of the ICP, instead, Accumulator bits 0 through 6 are loaded with "0's" while bit 7 is loaded with the logic level being applied to the EXT INT pin, thus allowing the status of EXT INT to be determined without the necessity of servicing an external interrupt request. When reading the Interrupt Control Port (port 6) bit 7 of the Accumulator is loaded with the actual logic level being applied to the EXT INT pin, regardless of the status of ICP bit 2 (the EXT INT Active Level bit), that is, if EXT INT is a + 5 V bit 7 of the Accumulator is set to a logic "1", but if EXT INT is at GND then Accumulator bit 7 is reset to logic "0" This capability is useful in establishing a high speed polled handshake procedure or for using EXT INT as an extra input pin if external interrupts are not required and the Timer is used only in the Interval Timer Mode However, if it is desirable to read the contents of the ICP then one of the 64 scratchpad registers or one byte of RAM may be used to save a copy of whatever is written to the ICP

The rate at which the timer is clocked in the Internal Timer Mode is determined by the frequency of an internal ϕ clock and by the division value selected for the prescaler (The internal ϕ clock operates at one-half the external time-base frequency) If ICP bit 5 is set and bits 6 and 7 are cleared, the prescaler divides ϕ by 2 Likewise, if bit 6 or 7 is individually set, the prescaler divides ϕ by 5 or 20 respectively. Combinations of bits 5, 6, and 7 may also be selected. For example, if bits 5 and 7 are set while 6 is cleared the prescaler will divide by 40 Thus, possible prescaler values are -2, -5, -10, -20, -40, -100, and -200

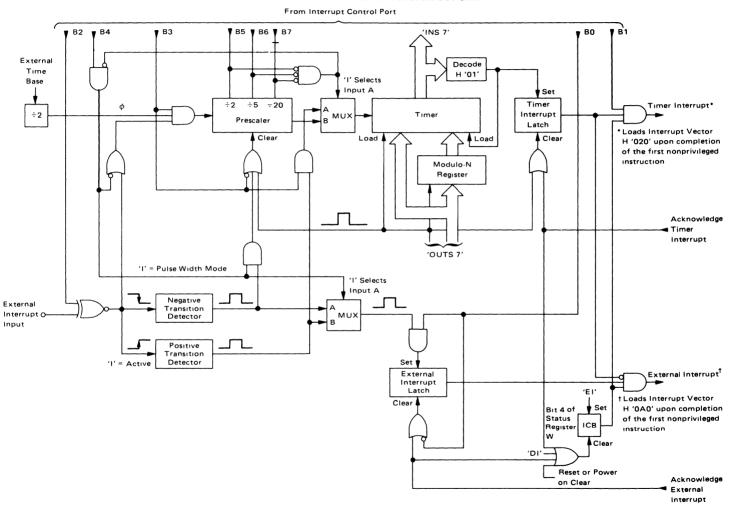
Any of three conditions will cause the prescaler to be reset whenever the timer is stopped by clearing ICP bit 3, execution of an output instruction to Port 7. (the timer is assigned port address 7), or on the trailing edge transition of the EXT INT pin when in the Pulse Width Measurement Mode These last two conditions are explained in more detail below

FIGURE 16 - TIMER AND CONTROL PORT BLOCK DIAGRAM



NOTE See Figure 17 for a more detailed functional diagram

FIGURE 17 - MC3870 TIMER/INTERRUPT FUNCTIONAL DIAGRAM



An OUT or OUTS instruction to Port 7 will load the content of the Accumulator to both the Timer and the 8-bit modulo-N register, reset the prescaler, and clear any previously stored timer interrupt request. As previously noted, the Timer is an 8-bit down counter which is clocked by the prescaler in the Interval Timer mode and in the Pulse Width Measurement Mode. The prescaler is not used in the Event Counter Mode. The modulo-N register is a buffer whose function is to save the value which was most recently outputted to Port 7. The modulo-N register is used in all three timer modes.

Interval Timer Mode - When ICP bit 4 is cleared (logic 0) and at least one prescale bit is set, the Timer operates in the Interval Timer Mode, when bit 3 of the ICP is set the Timer will start counting down from the modulo-N value After count:na down to H '01', the Timer returns to the modulo-N value at the next count. On the transition from H '01' to H 'N' the Timer sets a timer interrut request latch. Note that the interrupt request latch is set by the transition to H 'N' and not be the presence of H 'N' in the timer, thus allowing a full 256 counts if the modulo-N register is preset to H '00' If bit 1 of the ICP is set, the interrupt request is passed on to the CPU section of the MC3870 However, if bit 1 of the ICP is a logic 0 the interrupt request is not passed on to the CPU section but the interrupt request latch remains set. If ICP bit 1 is subsequently set, the interrupt request will then be passed on to the CPU section (Recall from the discussion of the Status Register's Interrupt Control Bit that the interrupt request will be acknowledged by the CPU section only if ICB is set) Only two events can reset the timer interrupt request latch when the timer interrupt request latch is acknowledged by the CPU section, or when a new load of the modulo-N register is performed

Consider an example in which the modulo-N register is loaded with H '64' (decimal 100). The timer interrupt request latch will be set at the 100th count following the timer start and the timer interrupt request latch will repeatedly be set on precise 100 counter intervals. If the prescaler is set at -40 the timer interrupt request latch will be set every 400 ϕ clock periods. For a 2 MHz ϕ clock (4 MHz time-base freugency) this will produce 2 millisecond intervals.

The range of possible intervals is from 2 to 51,200 ϕ clock periods (1 μ s to 25 6 ms for a 2 MHz clock). However, approximately 50 ϕ periods is a practical minimum because the time between setting the interrupt request latch and the execution of the first instruction of the interrupt service routine is at least 29 ϕ periods (the response time is dependent upon how many privileged instructions are encountered when the request occurs), 29 is based on the timer interrupt occuring at the beginning of a non-privileged short instruction. To establish time intervals greater than 51,200 ϕ clock periods is a simple matter of using the timer interrupt service routine to count the number of interrupts, saving the result in one or more of the scratchpad registers until the desired interval is achieved. With this technique virtually any time interval, or several time intervals, may be generated.

The Timer may be read at any time and in any mode using an input instruction (IN 7 or INS 7) and may take place "on the fly" without interfering with normal timer operation Also, the Timer may be stopped at any time by clearing bit 3 of the ICP The Timer will hold its current contents in-

definitely and will resume counting when bit 3 is again set Recall however that the prescaler is reset whenever the Timer is stopped, thus a series of starting and stopping will result in a cumulative truncation error

A summary of other timer errors is given in the timing section of their specification. For a free running timer in the Interval Timer Mode the time interval between any two interrupt requests may be in error by +6 \(\phi \) clock periods although the cumulative error over many intervals is zero. The prescaler and Timer generate precise intervals for setting the timer interrupt request latch but the time out may occur at any time within a machine cycle. (There are two types of machine cycles, short cycles which consist of 4 \upha clock periods and long cycles which consist of 6 ϕ clock periods) Interrupt requests are synchronized with the internal machine clock thus, giving rise to the possible $\pm 6 \phi$ error Additional errors may arise due to the interrupt request occuring while a privileged instruction or multicycle instruction is being executed. Nevertheless, for most applications all of the above errors are neglibible, especially if the desired time interval is greater than 1 ms

Pulse Width Measurement Mode — When ICP bit 4 is set (logic 1) and at least one prescale bit is set, the Timer operates in the Pulse Width Measurement Mode. This mode is used for accurately measuring the duration of a pulse applied to the EXT INT pin. The Timer is stopped and the prescaler is reset whenever EXT INT is at its inactive level. The active level of EXT INT is defined by ICP bit 2, if cleared, EXT INT is active low, if set, EXT INT is active high. If ICP bit 3 is set, the prescaler and Timer will start counting when EXT INT transitions to the active level. When EXT INT returns to the inactive level the Timer then stops, the prescaler resets, and if ICP bit 0 is set an external interrupt request latch is set (Unlike timer interrupts, external interrupts are not latched if the ICP Interrupt Enable bit is not set).

As in the Interval Timer Mode, the Timer may be read at any time, may be stopped at any time by clearing ICP bit 3, the prescaler and ICP bit 1 function as previously described, and the Timer still functions as an 8-bit binary down counter with the timer interrupt request latch being set on the Timer's transition from H '01' to H 'N' Note that the EXT INT pin has nothing to do with loading the Timer, its action is that of automatically starting and stopping the Timer and of generating external interrupts. Pulse widths longer than the prescale value times the modulo-N value are easily measured by using the timer interrupt service routine to store the number of timer interrupts in one or more scratchpad registers.

As for accuracy, the actual pulse duration is typically slightly longer than the measured value because the status of the prescaler is not readable and is reset when the Timer is stopped. Thus, for maximum accuracy, it is advisable to use a small division setting for the prescaler.

Event Counter Mode — When ICP bit 4 is cleared and all prescale bits (ICP bits 5, 6, and 7) are cleared, the Timer operates in the Event Counter Mode. This mode is used for counting pulses applied to the EXT INT pin. If ICP bit 3 is set, the Timer will decrement on each transition from the inactive level to the active level of the EXT INT pin. The prescaler is not used in this mode, but as in the other two timer modes,

the Timer may be read at any time, may be stopped at any time by clearing ICP bit 3, ICP bit 1 functions previously described, and the timer interrupt request latch is set on the Timer's transition from H '01' to H 'N'

Normally ICP bit 0 should be kept cleared in the Event Counter Mode, otherwise, external interrupts will be generated on the transition from the inactive level to the active level of the EXT INT pin

For the Event Counter Mode, the minimum pulse width required on EXT INT is 2 ϕ clock periods and the minimum inactive time is 2 ϕ clock periods, therefore, the maximum repetition rate is 500 kHz

External Interrupts — When the timer is in the Interval Timer Mode the EXT INT pin is available for non-timer related interrupts If ICP bit 0 is set, an external interrupt request latch is set when there is a transition from the inactive level to the active level of EXT INT (EXT INT is an edge-triggered input). The interrupt request is latched until either acknowledged by the CPU section or until ICP bit 0 is cleared (unlike timer interrupt requests which remain latched even when ICP bit 1 is cleared). External interrupts are handled in the same fashion when the Timer is in the Pulse Width Measurement Mode in the Pulse Width Measurement Mode the external interrupt request latch is set on the trailing edge of EXT INT, that is, on the transition from the active level to the inactive level.

INTERRUPT HANDLING

When either a timer or an external interrupt request is communicated to the CPU section of the MC3870, it will be acknowledged and processed at the completion of the first non-privileged instruction if the Interrupt Control Bit of the Status Register is set. If the Interrupt Control Bit is not set, the interrupt request will continue until either the Interrupt Control Bit is set and the CPU section acknowledges the interrupt or until the interrupt request is cleared as previously described.

If there is both a timer interrupt request and an external interrupt request when the CPU section starts to process the requests, the timer interrupt is handled first

When an interrupt is allowed the CPU section will request that the interrupting element pass its interrupt vector address to the Program Counter via the data bus. The vector

address for a timer interrupt is H '020'. The vector address for external interrupts is H '0A0'. After the vector address is passed to the Program Counter, the CPU section sends an acknowledge signal to the appropriate interrupt request latch which clears that latch. The execution of the interrupt service routine will then commence. The return address of the original program is automatically saved in the Stack Register, P.

The Interrupt Control Bit of W (Status Register) is automatically reset when an interrupt request is acknowledged. It is then the programmer's responsibility to determine when ICB will again be set (by executing an El instruction). This action prevents an interrupt service routine from being interrupted unless the programmer so desires.

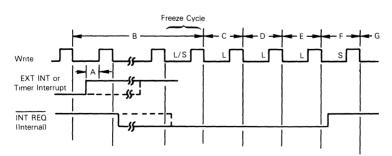
Figure 18 details the interrupt sequence which occurs whether the interrupt request is from an external source via EXT INT or from the MC3870's internal timer. Events are labeled with the letters A through G and are described below.

Event A — An interrupt request must satisfy a hold time requirement as specified in the AC Characteristics in order to guarantee that it is valid on the rising edge of the WRITE clock

Event B - Event B represents the instruction being executed when the interrupt occurs. The last cycle of B is normally the instruction fetch for the next cycle. However, if B is not a privileged instruction and the CPU's Interrupt Control Bit is set, then the last cycle becomes a "freeze" cycle rather than a fetch. At the end of the freeze cycle the interrupt request latches are inhibited from altering the interrupt daisychain so that sufficient time will be allowed for the daisychain to settle (If B is a privileged instruction, the instruction fetch is not replaced by a freeze cycle, instead, the fetch is performed and the next instruction is executed. Although unlikely to be encountered, a series of privileged instructions will be sequentially executed without interrupt. One more instruction, called a 'protected' instruction, will always be executed after the last privileged instruction. The last cycle of the protected instruction then performs the freeze)

The dashed lines on EXT INT illustrate the last opportunity for EXT INT to cause the last cycle of a non-protected instruction to become a freeze cycle

FIGURE 18 - INTERRUPT SEQUENCE



The freeze cycle is a short cycle (4 ϕ clock periods) in all cases except where B is the Decrement Scratchpad instruction, in which case the freeze cycle is a long cycle (6 ϕ clock periods).

INT REQ goes low on the next negative edge of WRITE if both PRI IN is low and the appropriate interrupt enable bit of the Interrupt Control Port is set. Both INT REQ and WRITE are internal signals

Event C - A NO-OP long cycle to allow time for the internal priority chain to settle

Event D — The Program Counter (PO) is pushed to the stack register (P) in order to save the return address. The interrupt circuitry places the lower 8 bits of the interrupt vector address onto the data bus. This is always a long cycle.

Event E-A long cycle in which the interrupt circuitry places the upper 8 bits of the interrupt vector address onto the data bus

Event F — A short cycle in which the interrupting interrupt request latch is cleared. Also, the CPU's interrupt Control Bit is cleared, thus disabling interrupts until an El instruction is performed. The fetch of the next instruction from the interrupt address

Event G — Begin execution of the first instruction of the interrupt service routine

SUMMARY OF INTERRUPT SEQUENCE

For the MC3870 the interrupt response time is defined as the time elapsed between the occurrence of EXT INT going active (or the Timer transitioning to H 'N') and the beginning of execution of the first instruction of the interrupt service routine. The interrupt response time is a variable dependent upon what the microprocessor is doing when the interrupt request occurs. As shown in Figure 18, the minimum interrupts of the contraction of the state of the contraction of the contractio

rupt response time is 3 long cycles plus 2 short cycles plus one WRITE clock pulse width plus a setup time of EXT INT prior to the leading edge of the WRITE pulse — a total of 27 ϕ clock periods plus the setup time. At a 2 MHz ϕ this is 14 25 μs . Although the maximum could theoretically be infinite, a practical maximum is 35 μs (based on the interrupt request occurring near the beginning of a PI and LR K, P sequence)

POWER-ON RESET

The intent of the Power-On Reset circuitry on the MC3870 is to automatically reset the device following a typical power-up situation, thus saving external reset circuitry in many applications. This circuitry is not guaranteed to sense a "Brown Out" (low voltage) condition nor is it guaranteed to operate under all possible power-on situations.

Three conditions are required before the MC387C will leave the reset state and begin operation. Refer to Figure 19 as an aid to the following descriptions. The On-Chip V_{CC} detector senses a minimum value of V_{CC} before it will allow the MC3870 to operate. The threshold of this detector is set by analog circuitry because a stable voltage reference is not available with n-channel MOS processing. Processing variations will cause this threshold to vary from a low of 3 0 volts to a high of 4 3 volts with 3 5 volts being typical.

The MC3870 uses a substrate bias as a technique to provide improved performances versus power consumption relative to conventional grounded substrate approaches This bias generator may start operating as low as VCC=3 volts on some devices while others may require VCC=4 volts in order to get adequate substrate bias. Until the substrate reaches the proper bias, the MC3870 will not be released from the reset state. The final condition required is that the clocks of the MC3870 must be functioning. Typically the clocks will start to function at VCC equal to 3 to 3 5 volts but since the part is tested at 4 5 volts, Motorola can not guarantee any operation below 4 5 volts. The output of the delay circuit in Figure 19 will stay low until the clocks.

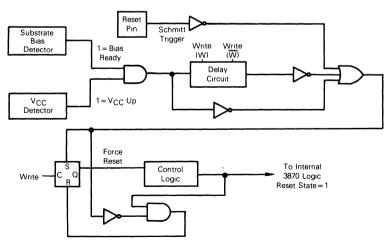


FIGURE 19 — POWER ON RESET BLOCK DIAGRAM

start to function If the input to the delay circuit is high, typically after 100 cycles of the WRITE clock (800 cycles of the external clock) the output of the delay circuit will go high allowing the MC3870 to begin execution

If VCC falls to ground for at least a few hundred nanoseconds the output of the delay circuit will go low immediately and the MC3870 will reset

The internal logic may detect a valid V_{CC}, bias and clocks at V_{CC} = 3 5 volts and allow the MC3870 to start executing after the time delay. With a slowly rising power supply, the part may start running before V_{CC} is above 4 5 volts which is below the guaranteed voltage range. When power-on-clear is required with a slowly rising power supply, an external capacitor must be used on the RESET pin to hold it below 0.8 volts until V_{CC} is stable above 4.5 volts. (Note The option to disconnect the internal pullup resistor on RESET is available which allows the use of a larger external pullup resistor and a small capacitor on RESET.)

In many applications it is desirable if the unit does an automatic power-on-clear, but not mandatory. The unit will have a RESET push button and if the unit does not power-up correctly or malfunctions because of some disturbance on the VCC line, the operator will simply press RESET and restore normal operation. It is for these applications that the internal power-on-clear circuitry was designed.

In some applications it is required that the microcomputer continue to run properly without operator intervention after brown-outs, power line disturbances, electrical noise, computer malfunction due to a programming bug, or any other disturbance except a catastrophic failure of some component

One concept used to keep computers running is that of the "WATCHDOG TIMER" The computer is programmed to periodically reset the watchdog timer during the normal execution of its program (this is easily done in the MC3870 as its normal application is in some control function which is typically periodic) As long as the computer continues to execute its program the watchdog timer is continually reset and never times out. Should the computer stop executing its program for whatever reason, the watchdog timer will time out producing a RESET pulse to the CPU re-starting execution This is a very positive way to assure that the computer is doing its job, i.e., executing the program. It is important that the software driving the watchdog timer test as many functional blocks (timer, ALU, scratchpad RAM, and ports) of the MC3870 as possible before resetting the watchdog timer This is because operation of the MC3870, with an out of specification power supply, may allow some of the functions to operate correctly while other functions are not

Motorola can guarantee correct operation of the MC3870 only while the VCC voltage remains within its specified limits. If proper operation of the MC3870 must be guaranteed after a disturbance on the VCC line, then an external circuit must be used to monitor the VCC line and produce \overline{RESET} to the MC3870 whenever VCC is out of the specified limits.

A related characteristic to power-on-clear is the startup time of the basic timing element. The LC and RC oscillators begin to function almost immediately once V_{CC} is high enough to allow the on-board oscillator to operate (VCC=35V). Operation with a crystal is partly mechanical and some start time is required to get the mass of the crystal

into vibrational motion. This time is basically dependent on the frequency (mass) of the crystal. 4 MHz crystals typically require about 2-3 ms to start while 1 MHz crystals require 60-70 ms to start oscillating. Of course, this time may vary greatly from crystal to crystal and is also a function of the power supply rise time characteristic, however, the high-frequency crystals start faster and are definitely recommended (i.e., 3-4 MHz).

The condition of the port pins during the power-in-clear sequence is often asked. The port pins or the STROBE line cannot be specified until VCC reaches 4.5 V and the MC3870 enters the RESET state. Before this, the port pins may stay at VSS, may track VCC as it rises, or they may track VCC part way up then return to VSS (ports 4 and 5 will go to VCC once the clocks are running and the MC3870 has sufficient VCC to properly operate the internal control logic and I/O ports).

EXTERNAL RESET

When RESET is taken low, the content of the Program Counter is pushed to the Stack Register and then the Program Counter and the ICB bit of the W Status Register are cleared The original Stack Register content is lost Ports 4, 5, 6, and 7 are loaded with H '00' The contents of all other registers and ports are unchanged or undefined When RESET is taken high, the first program instruction is fetched from ROM location H '000' When an external reset of the MC3870 occurs, P0 is pushed into P and the old contents of P are lost It must be noted that an external reset is recognized at the start of a machine cycle and not necessarily at the end of an instruction. Thus, if the MC3870 is executing a multi-cycle instruction, that instruction is not completed and the contents of P upon reset may not necessarily be the address of the instruction that would have been executed next It may, for example, point to an immediate operand if the reset occurred during the second cycle of an LI or CI instruction Additionally, several instructions (JMP, PI, PI, LR, PO, Q) as well as the interrupt acknowledge sequence modify P0 in parts. That is, they alter P0 by first loading one part then the other and the entire operation takes more than one cycle Should reset occur during this modification process the value pushed into P will be part of the old P0 (the as yet unmodified part) and part of the new PO (already modified part) Thus, care should be taken (perhaps by external gating) to insure that reset does not occur at an undesirable time if any significance is to be given to the contents of P after a reset occurs

VCC DECOUPLING

The MC3870 family devices have dynamic circuitry internally which requires a good high frequency decoupling capacitor to surpress noise on the VCC line A 0.01 μF or 0.1 μF ceramic capacitor should be placed between VCC and ground, located physically close to the MC3870 device. This will reduce noise generated by the MC3870 to about 70-100 mV on the VCC line

TEST LOGIC

Special test logic is implemented to allow access to the internal main data bus for test purposes

In normal operation, the TEST pin is unconnected or is connected to GND. When TEST is placed at a TTL level $(2\ 0\ V\ to\ 2\ 6\ V)$ port 4 becomes an output of the internal data

bus The data appearing on the port 4 pins is logically true whereas input data forced on port 5 must be logically false When TEST is placed at a high level (6 0 V to 7 0 V), the ports act as above and additionally the 2K × 8 program ROM is prevented from driving the data bus in this mode, operands and instructions may be forced externally through port 5 instead of being accessed from the program ROM When TEST is in either the TTL state or the high state, STROBE ceases its normal function and becomes a machine cycle clock (identical to the F8 multi-chip system WRITE clock except inverted)

Timing complexities render the capabilities associated with the TEST pin impractical for use in a user's application, but these capabilities are thoroughly sufficient to provide a rapid method for thoroughly testing the MC3870

SUPPLEMENTARY NOTES

The Interrupt Control Bit of the W Status Register is automatically reset when an interrupt request is acknowledged. It is then the programmer's responsibility to determine when ICB will again be set (by execution an El instruction). This action prevents an interrupt service routine from being interrupted unless the programmer so desires.

When reading the Interrupt Control Port (port 6), bit 7 of the Accumulator is loaded with the actual logic level being applied to the EXT INT pin, regardless of the status of ICP bit 2 (the EXT INT Active Level bit). This is, if EXT INT is at

 $+\,5$ V, bit 7 of the Accumulator is set to a logic "1", but, if EXT INT is at GND, then Accumulator bit 7 is reset to logic "0"

In the MC3870 (F8 COMPATIBLE) INSTRUCTION SET summary, the number of cycles shown are "nominal" machine cycles A nominal machine cycle is defined as 4 ϕ clock periods, thus, requiring 2 μ s for a 2 MHz ϕ clock frequency (4 MHz external time-base frequency)

Also, the summary uses an older nomenclature for register names. The translation is as follows

PC0 = P0 Program Counter
PC1 = P Stack Register

PC1 = P Stack Register
DC0 = DC Data Counter

DC1 = DC1 Auxiliary Data Counter

The nomenclature is used in order to be consistent with the assembly language mnemonics

For the MC3870, execution of an INS or OUTS instruction requires 2 machine cycles for ports 0 and 1, whereas ports 4 and 5 require 4 machine cycles

INSTRUCTION EXECUTION

This section details the timing and execution of the MC3870 instruction set Refer to Figure 20 for a MC3870 Programming Model

FIGURE 20 - MC3870 PROGRAMMING MODEL DI OUTS 7 Status Timer o z c INS* 7 Ports 4 3 2 1 0 LISL OUTS 6 Int Cntl IS INS* 6t Ports LISU Scratchpad OUTS 0, 1, 4, 5 Registers 1/0 0 Ports INS* 0, 1, 4, 5 AS* (4) NS 2 xs H Aux Data 3 3 ASD A1* Counter 4 NI 5 01 DC1‡ Accumulator 6 XDC LR ROM ΧI 7 MEM 8 10 2048×8 XDC LR LI, LIS 11 9 сом' DC1 A U 12 INC DC‡ В L 13 LR SL1 С U 14 is SL4 - DS * Data Counter D L 15 SR1 U 16 SR4 ROM Stack Reg L 17 Mem 2048 × 8 10 20 POP 11 21 NM BT BF ОМ 3C 74 3D 75 PO_‡ (0) JMP, PI2 3E 76 Program 3F 77 LM Counter Octal Hex (DC) Int. Vector Reset Transfers PO to P and From then clears PO, ICB Bit of W H '020' and Ports 4, 5, 6, and 7 H '0A0' * These instructions set status † The value of the external interrupt input is loaded to Bit 7 of the accumulator (with Bits 0 through 6 loaded with zeros) RESET H '000' when the instruction 'INS 6' is executed. This instruction also sets status External Interrupt ††P0, P, DC, and DC1 are 12-bit registers

NOTE The Instructions PI and PK are shown in two sequential parts (PI¹, PI² and PK¹, PK²).

MC3870 INSTRUCTION SET

ACCUMULATOR GROUP INSTRUCTIONS

| 0 | Mnemonic | 0 | F | Machine | | Cyc | cles | | | Statu | s Bits | |
|------------------------|----------|---------|-----------------------------------|------------------|-------|-------|------|----------|-----|-------|--------|------|
| Operation | Op Code | Operand | Function | Code | Bytes | Short | Long | (2 MHzφ) | OVR | ZERO | CRY | SIGN |
| Add Carry | LNK | | A ← (A) + CR r' | 19 | 1 | 1 | | 2 | 1/0 | 1/0 | 1/0 | 1/0 |
| Add Immediate | ΑI | 11 | A ← (A) + H'ıı' | 2411 | 2 | 1 | 1 | 5 | 1/0 | 1/0 | 1/0 | 1/0 |
| And Immediate | NI | н | $A \leftarrow (A)\Lambda H' \Pi'$ | 2111 | 2 | 1 | 1 | 5 | 0 | 1/0 | 0 | 1/0 |
| Clear | CLR | | A H'00' | 70 | 1 | 1 | | 2 | - | - | _ | _ |
| Compare Immediate | CI | 11 | $H'_{11}' + (A) + 1$ | 25 ₁₁ | 2 | 1 | 1 | 5 | 1/0 | 1/0 | 1/0 | 1/0 |
| Complement | COM | | A (A) + H'FF' | 18 | 1 | 1 | | 2 | 0 | 1/0 | 0 | 1/0 |
| Exclusive or Immediate | ΧI | н | A ← (A) + H'II' | 2311 | 2 | 1 | 1 | 5 | 0 | 1/0 | 0 | 1/0 |
| Increment | INC | | $A \leftarrow (A) + 1$ | 1F | 1 | 1 | | 2 | 1/0 | 1/0 | 1/0 | 1/0 |
| Load Immediate | LI | 11 | A ← H'ıı' | 20n | 2 | 1 | 1 | 5 | | | - | - |
| Load Immediate Short | LIS | 1 | A ← H'0ı' | 71 | 1 | 1 | | 2 | | | | |
| OR Immediate | OI | | A ← (A)vH'ıı' | 2211 | 2 | 1 | 1 | 5 | 0 | 1/0 | 0 | 1/0 |
| Shift Left One | SL | 1 | Shift Left 1 | 13 | 1 | 1 | | 2 | 0 | 1/0 | 0 | 1/0 |
| Shift Left Four | SL | 4 | Shift Left 4 | 15 | 1 | 1 | | 2 | 0 | 1/0 | 0 | 1/0 |
| Shift Right One | SR | 1 | Shift Right 1 | 12 | 1 | 1 | | 2 | 0 | 1/0 | 0 | 1 |
| Shift Right Four | SR | 4 | Shift Right 4 | 14 | 1 | 1 | | 2 | 0 | 1/0 | 0 | 1 |

BRANCH INSTRUCTIONS in all conditional branches P0 ← (P0) + 2 if the test condition is not met Execution is complete in 3 short cycles

| Operation | Mnemonic | Operand | Function | Machine | | Cyc | | | | Status | | |
|------------------------------|------------------|-------------|--|---------|-------|-------|------|-----------|-----|--------|-----|------|
| Operation | Op Code | Operand | runction | Code | Bytes | Short | Long | (2 MHz φ) | OVR | ZERO | CRY | SIGN |
| Branch on Carry | ВС | aa | P0 ← (P0) + 1 + H'aa' if CRY = 1 | 82aa | 2 | 2 | 1 | 7 | - | - | - | _ |
| Branch on Positive | ВР | aa | P0 ← (P0) + 1 + H'aa' if SIGN = 1 | 81aa | 2 | 2 | 1 | 7 | _ | - | - | - |
| Branch on Zero | BZ | aa | P0 ← (P0) + 1 + 'Haa' if Zero = 1 | 84aa | 2 | 2 | 1 | 7 | - | - | - | - |
| Branch on True | вт | taa | P0 ← (P0) + 1 + 'Haa' | 8taa | 2 | 2 | 1 | 7 | | _ | | |
| | TEST CON | | if any test is true | | | | | | | | | |
| | 22 2 ZERO CR | 20 SIGN | | | | | | | | | | |
| Branch if Negative | 8M | aa | P0 ← (P0) + 1 + H'aa' If SIGN = 0 | 91aa | 2 | 2 | 1 | 7 | - | - | - | - |
| Branch if No Carry | BNC | aa | P0 ← (P0) + 1 + H'aa' of CARRY = 0 | 92aa | 2 | 2 | 1 | 7 | | | - | - |
| Branch if No Overflow | BNO | аа | $P0 \leftarrow (P0) + 1 + H'aa'$ If $OVR = 0$ | 98aa | 2 | 2 | 1 | 7 | - | - | | - |
| Branch if Not Zero | BNZ | aa | P0 ← (P0) + 1 + H'aa' If ZERO = 0 | 94aa | 2 | 2 | 1 | 7 | _ | | - | - |
| Branch if False Test | BF EST CONDI | taa FION | P0 ← (P0) + 1 + H'aa' If all false test bits | 9taa | 2 | 2 | 1 | 7 | - | - | - | - |
| 2' OVF | 2' 2' ZERO CR | 2' SIGN | | | | | | | | | | |
| Branch if ISAR (Lower) ≠7 | BR7 | aa | P0 ← (P0) + 1 + H'aa' ISARL ≠ 7 P0 ← (P0) + 2 if | 8Faa | 2 | 2 | 1 | 5 | - | _ | - | - |
| | | | ISARL=7 | | 2 | 2 | | 4 | _ | _ | _ | _ |
| Branch Relative | BR | aa | P0 ← (P0) + 1 + H'aa' | 90aa | 2 | 2 | 1 | 7 | _ | _ | | _ |
| Jump* | JMP | aaaa | PO ← H'aaaa' | 29aaaa | 3 | 1 | 3 | 11 | _ | _ | _ | _ |

^{*}Privileged instruction, accumulator contents altered during execution JMP

MEMORY REFERENCE INSTRUCTIONS In all Memory Reference Instructions, the Data Counter is incremented DC ← (DC) + 1

| 0 | Mnemonic | 0 | F | Machine | | Cy | cles | | | Statu | s Bits | |
|--------------|----------|---------|------------------------------------|---------|-------|-------|------|-----------|-----|-------|--------|------|
| Operation | Op Code | Operand | Function | Code | Bytes | Short | Long | (2 MHz φ) | OVR | ZERO | CRY | SIGN |
| Add Binary | AM | | A ← (A) + [(DC)] | 88 | 1 | 1 | 1 | 5 | 1/0 | 1/0 | 1/0 | 1/0 |
| Add Decimal | AMD | | A ← (A) + [(DC)]• BCD Adjust | 89 | 1 | 1 | 1 | 5 | 1/0 | 1/0 | 1/0 | 1/0 |
| AND | NM | | $A \leftarrow (A)\Lambda[(DC)]$ | 8A | 1 | 1 | 1 | 5 | 0 | 1/0 | 0 | 1/0 |
| Compare | CM | | [(DC)] + (A) + 1 | 8D | 1 | 1 | 1 | 5 | 1/0 | 1/0 | 1/0 | 1/0 |
| Exclusive OR | XM | | $A \leftarrow (A) \oplus \{(DC)\}$ | 8C | 1 | 1 | 1 | 5 | 0 | 1/0 | 0 | 1/0 |
| Load | LM | | A ← [(DC)] | 16 | 1 | 1 | 1 | 5 | | - | - | - |
| Logical OR | ОМ | | $A \leftarrow (A)v[(DC)]$ | 88 | 1 | 1 | 1 | 5 | 0 | 1/0 | 0 | 1/0 |
| Store | ST | | A ← [(DC)] | 17 | 1 | 1 | 1 | 5 | - | - | _ | |

ADDRESS REGISTER GROUP INSTRUCTIONS

| 0 | Mnemonic | 0 | Function | Machine | | Cyc | cles | | | | s Bits | |
|----------------------------------|----------|---------|--|---------|-------|-------|------|-----------|-----|------|--------|------|
| Operation | Op Code | Operand | runction | Code | Bytes | Short | Long | (2 MHz φ) | OVR | ZERO | CRY | SIGN |
| Add to Data Counter | ADC | | DC ← (DC) + (A) | 8E | 1 | 1 | 1 | 5 | | | - | _ |
| Call to Subroutine* | PK | | POU ← (r12), POL ← (r13), P ← (P0) | 0C | 1 | 1 | 2 | 8 | - | - | - | - |
| Call to Subroutine Immediate* | PI | aaaa | P ← (P0), P0 ← H'aaaa | 28aaaa | 3 | 2 | 3 | 13 | | - | - | - |
| Exchange DC | XDC | | (DC) - (DC1) | 2C | 1 | 2 | | 4 | - | | - | - |
| Load Data Counter | LR | DC, Q | DCU ← (r14), DCL ← (r15) | OF | 1 | 1 | 2 | 8 | - | - | - | - |
| Load Data Counter | LR | DC, H | DCU←(r10), DCL←(r11) | 10 | 1 | 1 | 2 | 8 | - | - | - | - |
| Load DC Immediate | DCI | aaaa | DC H'aaaa' | 2Aaaaa | 3 | 3 | 2 | 12 | _ | - | - | - |
| Load Program Counter | LR | P0, Q | POU ← (r14), POL ← (r15) | OD | 1 | 1 | 2 | 8 | - | - | - | - |
| Load Stack Register | LR | P, K | PU ← (r12), PL←r13) | 09 | 1 | 1 | 2 | 8 | - | - | | - |
| Return from Subroutine* | POP | | P0 (P) | 1C | 1 | 2 | | 4 | - | _ | - | - |
| Store Data Counter | LR | Q, DC | r14 ← (DCU), r15 ← (DCL) | OE | 1 | 1 | 2 | 8 | - | - | - | - |
| Store Data Counter | LR | H, DC | r10← DCU, r11←(DCL) | 11 | 1 | 1 | 2 | 8 | - | - | - | - |
| Store Stack Register | LR | K, P | r12←(PU), r13←(PL) | 08 | 1 | 1 | 2 | 8 | - | - | - | *** |

SCRATCHPAD REGISTER INSTRUCTIONS (Refer to Scratchpad Addressing Modes)

| | Mnemonic | | | Machine | | Cyc | les | | | Statu | s Bits | |
|--------------|----------|---------|------------------------------|---------|-------|-------|------|-----------|-----|-------|--------|------|
| Operation | Op Code | Operand | Function | Code | Bytes | Short | Long | (2 MHz φ) | OVR | ZERO | CRY | SIGN |
| Add Binary | AS | r | A ← (A) + (r) | Cr | 1 | 1 | | 2 | 1/0 | 1/0 | 1/0 | 1/0 |
| Add Decimal | ASD | r | $A \leftarrow (A) + (r)$ | Dr | 1 | 2 | | 4 | 1/0 | 1/0 | 1/0 | 1/0 |
| Decrement | DS | r | $r \leftarrow (r) + H'FF'$ | 3r | 1 | | 1 | 3 | 1/0 | 1/0 | 1/0 | 1/0 |
| Load | LR | A, r | A ← (r) | 4r | 1 | 1 | | 2 | - | | - | - |
| Load | LR | A, KU | A ← (r12) | 00 | 1 | 1 | | 2 | _ | _ | - | - |
| Load | LR | A, KL | A ← (r13) | 01 | 1 | 1 | | 2 | - | - | - | |
| Load | LR | A, QU | A ← (r14) | 02 | 1 | 1 | | 2 | - | - | _ | |
| Load | LR | A, QL | A ← (r15) | 03 | 1 | 1 | | 2 | | - | | |
| Load | LR | r, A | r ← (A) | 5r | 1 | 1 | | 2 | - | - | _ | |
| Load | LR | KU, A | r12 ← (A) | 04 | 1 | 1 | | 2 | _ | - | - | |
| Load | LR | KL, A | r13←(A) | 05 | 1 | 1 | | 2 | | - | _ | _ |
| Load | LR | QU, A | r14 ← (A) | 06 | 1 | 1 | | 2 | - | - | - | |
| Load | LR | QL, A | r15 ← (A) | 07 | 1 | 1 | | 2 | _ | - | _ | _ |
| AND | NS | r | $A \leftarrow (A)\Lambda(r)$ | Fr | 1 | 1 | | · 2 | 0 | 1/0 | 0 | 1/0 |
| Exclusive OR | XS | r | $A \leftarrow (A) + (r)$ | Er | 1 | 1 | | 2 | 0 | 1/0 | 0 | 1/0 |

^{*}Privileged instruction, accumulator contents altered during execution of PI instruction

MISCELLANEOUS INSTRUCTIONS

| Operation | Mnemonic Op Code | Operand | Function | Machine Code | Bytes | Cyc Short | les Long | (2 MHz φ) | OVR | Statu ZERO | | SIGN |
|-----------------------|---------------------|-------------|-----------------------------|-----------------|-------|--------------|-------------|-----------|-----|---------------|-----|------|
| Disable Interrupt | DI | | Reset ICB | 1A | 1 | 1 | | 2 | | _ | | _ |
| Enable Interrupt* | El | | Set ICB | 1B | 1 | 1 | | 2 | - | _ | _ | _ |
| Input | IN | 04,05,06,07 | A ← (Input Port aa) | 26aa | 2 | 1 | 2 | 8 | 0 | 1/0 | 0 | 1/0 |
| Input Short | INS | 0, 1 | A ← (Input Port 0 or 1) | A0,A1 | 1 | 2 . | | 4 | 0 | 1/0 | 0 | 1/0 |
| Input Short | INS | 4,5,6,7 | A ← (Input Port a) | Aa | 1 | 1 | 2 | 8 | 0 | 1/0 | 0 | 1/0 |
| Load ISAR | LR | IS,A | IS ← (A) | OB | 1 | 1 | | 2 | | - | *** | _ |
| Load ISAR Lower | LISL | bbb | ISL ← bbb | 6(0bbb)** | 1 | 1 | | 2 | | _ | | - |
| Load ISAR Upper | LISU | bbb | ISU ← bbb | 6(1bbb)** | 1 | 1 | | 2 | _ | - | - | - |
| Load Status Register* | LR | U,W | W ← (r9) | 1D | 1 | 2 | | 4 | 1/0 | 1/0 | 1/0 | 1/0 |
| No Operation | NOP | \$ | P0 ← (P0) + 1 | 2B | 1 | 1 | | 2 | _ | - | _ | _ |
| Output* | OUT | 04,05,06,07 | Output Port aa ← (A) | 27aa | 2 | 1 | 2 | 8 | - | - | - | - |
| Output Short | OUTS | 0, 1 | Output Port 0 or 1 ← (A) | B0,B1 | 1 | 2 | | 4 | | - | - | - |
| Output Short | OUTS | 4,5,6,7 | Output Port a ← (A) | Ba | 1 | 1 | 2 | 8 | | _ | | |
| Store ISAR | LR | A,IS | A ← (IS) | 0A | 1 | 1 | | 2 | | _ | _ | - |
| Store Status Reg | LR | J,W | r9 ← (W) | 1E | 1 | 1 | | 2 | | _ | - | - |

NOTES

| Lower case | denotes variables specified by programmer | KL | Register 13 |
|------------|--|---------------|--|
| Function | Definitions | KU P0 | Register 12 Program Counter |
| - | is replaced by | P0L | Least Significant 8 Bits of Program Counter |
| () | the contents of | P0U | Most Significant 8 bits of Program Counter |
| () | Binary "1s" complement of | Р | Stack Register |
| + | Arithmetic Add (Binary or Decimal) | PL | Least Significant 8 bits of Program Counter |
| ⊕ | Logical "OR" exclusive | PU | Most Significant 8 bits of Active Stack Register |
| Λ | Logical "AND" | Q | Registers 14 and 15 |
| V | Logical "OR" inclusive | QL | Reigster 15 |
| H" | Hexadecimal digit | QU | Register 14 |
| [()] | Contents of memory specified by () | r | Scratchpad Register (any address 0 through B) |
| а | Address Variable (four bits) | | (See Below) |
| Α | Accumulator | W | Status Register |
| b | One bit immediate operand | Scratchpad | Addressing Modes Using IS. (r≠0 through B) |
| DC DC1 | Data Counter (Indirect Address Register) | r = H'C' | Register Addressed by IS is (Unmodified) |
| DC1 DCL | Data Counter 1 (Auxiliary Data Counter) | r = H'D' | Register Addressed by IS is Incremented |
| | Least significant 8 bits of Data Counter Addressed | r = H'E' | Register Addressed by IS is Decremented |
| DCU | Most significant 8 bits of Data Counter Addressed | r = H'F' | Illegal OP Code |
| Н | Scratchpad Register 10 and 11 | Status Regis | - |
| ICD | Immediate operand (four bits) | Otatas riogii | |
| ICB | Interrupt Control Bit | 1/0 | No change in condition |
| IS | Indirect Scratchpad Address Register | 1/0 | is set to "1" or "0" depending on conditions |
| ISL | Least Significant 3 bits of ISAR | CRY | Carry Flag |
| ISU | Most Significant 3 bits of ISAR | OVR | Overflow Flag |
| J | Scratchpad Register 9 | SIGN | Sign of Result Flag |
| K | Registers 12 and 13 | ZERO | Zero Flag |

^{*}Privileged instruction

**b = 1-bit immediate operand

ORDERING INFORMATION

The following information is required when ordering a custom MCU. This information may be transmitted to Motorola in the following media.

PROM(s) MCM2716s or MCM2708s

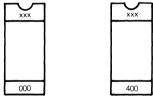
MDOS disk file

To initiate a ROM pattern for the MCU it is necessary to first contact your local field service office, local sales person, or your local Motorola representative

PROMs — The MCM2708 or MCM2716 type PROMs, programmed with the customer program (positive logic sense for address and data), may be submitted for pattern generation. The PROMs must be clearly marked to indicate which PROM corresponds to which address space (000-3FF HEX), (400-7FF) or (000-7FF). See Figure 21 for recommended marking procedure.

After the PROM(s) are marked they should be placed in conductive IC carriers and securely packed. Do not use styrofoam

FIGURE 21 - PROM MARKING



xxx = Customer ID

VERIFICATION MEDIA

All original pattern media (PROMs or Floppy Disk) are filed for contractual purposes and are not returned. A computer listing of the ROM code will be generated and returned along

with a listing verification form. The listing should be thoroughly checked and the verification form completed, signed, and returned to Motorola. The signed verification form constitutes the contractual agreement for creation of the customer mask. If desired, Motorola will program a blank 2716 EPROM (supplied by the customer) from the data file used to create the custom mask to aid in the verification process.

ROM VERIFICATION UNITS

Ten MC3870s containing the customer's ROM pattern will be sent for program verification. These units will have been made using the custom mask but are for the purpose of ROM verification only. For expediency they are usually unmarked, packaged in ceramic, and tested only at room temperature and 5 volts. These RVUs are included in the mask charge and are not production parts.

FLEXIBLE DISKS

The disk media submitted must be single-sided, singledensity, 8-inch, MDOS compatible floppies. The customer must write the binary file name and company name on the disk with a felt-tip pen. The floppies are not to be returned by Motorola as they are used for archival storage. The minimum MDOS system files must be on the disk as well as the absolute binary object file itiiename LO type of file) from the MC3870 cross assembler An object file made from a memory dump using the ROLLOUT command is also admissable Consider submitting a source listing as well as the following files filename LX (EXORciser® loadable format) and filename SA (ASCII Source Code) These files will of course be kept confidential and are used 1) to speed up the process in house if any problems arise, and 2) to speed up our customer to factory interface if a user finds any software errors and needs assistance quickly from the factory representatives

MDOS is Motorola's Disk Operating System available on development systems such as EXORcisers, or EXORsets, etc.

MC3870 ORDERING INFORMATION

| Date | Customer PO N | lumber | |
|--------------------------------|---|------------|---------------|
| Customer Name | | | |
| Address | | | |
| | | | Zıp |
| | | | |
| Country | | | |
| Phone | Ex | tension | |
| Contact | | | |
| Customer Part Number | | | |
| _ | | | |
| Options | Reset | Pullup 🗖 | No Pullup 🗖 |
| | | | |
| | External Interrupt | Pullup 🗖 | No Pullup 🔲 |
| Port Options | | | |
| | Standard TTL | Open Drain | Direct Drive |
| P4-0 | | | |
| P4-1 | | | |
| P4-2 P4-3 | | | |
| P4-4 | | | |
| P4-5 | | _ | _ |
| P4-6 | = | | 00000000000 |
| P4-7 | | | |
| P5-0 | 0 0 0 0 0 | | |
| P5-1 | | | |
| P5-2 | | | |
| P5-3 | | | |
| P5-4 P5-5 | | | |
| Į. | | 님 | |
| P5-6 P5-7 | | | |
| Pattern Media | | | |
| PROMs (MCM2716 | or MCM2708) | — · | Floppy Disk |
| | In two extra PROMs, | · | торру Бізк |
| Motorola will progra | am the customer's Ms for code verification | | Other |
| code on these i no | WIS for Code Vermedien | | |
| Clock Mode | | XTAL | RC LC Extern |
| Clock Freq | | | |
| , | | | |
| Temp Range | | 0-70 | °C — 40-+85°C |
| Marking Information (12 Charac | eters Maximum) | | |
| * | | | |
| | | | |
| NOTE All other media requires | prior factory approval | | |



8-BIT MICROPROCESSING UNIT (MPU)

The MC6800 is a monolithic 8-bit microprocessor forming the central control function for Motorola's M6800 family. Compatible with TTL, the MC6800, as with all M6800 system parts, requires only one ± 5 0-volt power supply, and no external TTL devices for bus interface.

The MC6800 is capable of addressing 64K bytes of memory with its 16-bit address lines. The 8-bit data bus is bidirectional as well as three-state, making direct memory addressing and multiprocessing applications realizable.

- 8-Bit Parallel Processing
- Bidirectional Data Bus
- 16-Bit Address Bus 64K Bytes of Addressing
- 72 Instructions Variable Length
- Seven Addressing Modes Direct, Relative, Immediate, Indexed, Extended, Implied and Accumulator
- Variable Length Stack
- Vectored Restart
- Maskable Interrupt Vector
- Separate Non-Maskable Interrupt Internal Registers Saved in Stack
- Six Internal Registers Two Accumulators, Index Register, Program Counter, Stack Pointer and Condition Code Register
- Direct Memory Addressing (DMA) and Multiple Processor Capability
- Simplified Clocking Characteristics
- Clock Rates as High as 2.0 MHz
- Simple Bus Interface Without TTL
- Halt and Single Instruction Execution Capability

MAXIMUM RATINGS

| Rating | Symbol | Value | Unit |
|--|------------------|--|------|
| Supply Voltage | Vcc | -0.3 to +7.0 | V |
| Input Voltage | V _{in} | -0.3 to +7.0 | ٧ |
| Operating Temperature Range MC6800, MC68A00, MC68B00 MC6800C, MC68A00C | TA | T _L to T _H 0 to +70 -40 to +85 | °C |
| Storage Temperature Range | T _{stg} | - 55 to + 150 | °C |

THERMAL RESISTANCE

| Rating | Symbol | Value | Unit |
|-----------------|---------------|-------|------|
| Plastic Package | | 100 | |
| Cerdip Package | θ_{JA} | 60 | °C/W |
| Ceramic Package | | 50 | 1 |

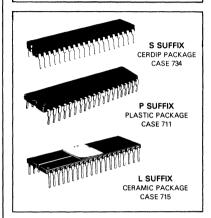
This device contains circuitry to protect the inputs against damage due to high static voltages or electrical fields, however, it is advised that normal precautions be taken to avoid application of any voltage higher than maximum-rated voltages to this high-impedance circuit. Reliability of operation is enhanced if unused inputs are tied to an appropriate logic voltage (e.g., either Vs.S. or Vc.C.)

MC6800 (1.0 MHz) MC68A00 (1.5 MHz) MC68B00 (2.0 MHz)

MOS

(N-CHANNEL, SILICON-GATE, DEPLETION LOAD)

MICROPROCESSOR



| PIN ASSIGNMENT | | | | |
|----------------------------|-----------------------------|--|--|--|
| Vss I 1 | 40 RESET | | | |
| HALT C 2 | 39 1 TSC | | | |
| φ 1 []3 | 38] N C | | | |
| IRQ C 4 | 37 □ φ 2 | | | |
| VMA L 5 | 36 □ DBE | | | |
| <mark>имі⊏6</mark> | 35 1 N C | | | |
| ВА Г 7 | 34 □ R/₩ | | | |
| ۷ _{CC} t 8 | 33 1 D0 | | | |
| A0 9 | 32 1 D1 | | | |
| A1 [10 | 31 1 D2 | | | |
| A2 [11 | 30 µ D3 | | | |
| A3 [12 | 29 1 D4 | | | |
| A4 [13 | 28] D5 | | | |
| A5 [14 | 27 1 D6 | | | |
| A6 [15 | 26 1 D7 | | | |
| A7 [16 | 25 1 A15 | | | |
| A8 L 17 | 24 🗖 A14 | | | |
| A9 [18 | 23] A13 | | | |
| A10 1 19 | 22 1 A12 | | | |
| A11 1 20 | 21 1 V _{SS} | | | |

POWER CONSIDERATIONS

The average chip-junction temperature, T_J, in °C can be obtained from:

$$T_{J} = T_{A} + (P_{D} \bullet \theta_{JA}) \tag{1}$$

Where:

 $T_A = Ambient Temperature, °C$

 θ JA = Package Thermal Resistance, Junction-to-Ambient, °C/W

PD = PINT + PPORT

PINT≡ICC×VCC, Watts - Chip Internal Power

PPORT = Port Power Dissipation, Watts - User Determined

For most applications PPORT ◀PINT and can be neglected. PPORT may become significant if the device is configured to drive Darlington bases or sink LED loads.

An approximate relationship between PD and TJ (if PPORT is neglected) is:

$$P_D = K + (T_J + 273^{\circ}C)$$
 (2)

Solving equations 1 and 2 for K gives: $K = P_D \bullet (T_A + 273 \circ C) + \theta_{JA} \bullet P_D^2$

(3)

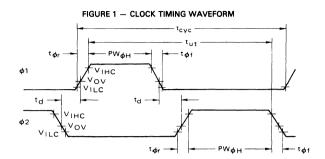
Where K is a constant pertaining to the particular part. K can be determined from equation 3 by measuring PD (at equilibrium) for a known TA. Using this value of K the values of PD and TJ can be obtained by solving equations (1) and (2) iteratively for any value of TA.

DC ELECTRICAL CHARACTERISTICS (V_{CC} = 5 0 Vdc, ±5%, V_{SS} = 0, T_A = T_L to T_H unless otherwise noted)

| Characteristic | | Symbol | Min | Тур | Max | Unit |
|--|-----------------------------------|-------------------------------------|---|-----------------------|--|------|
| Input High Voltage | Logic φ1, φ2 | V _{IH} V _{IHC} | V _{SS} +20 V _{CC} -06 | | V _{CC} + 0 3 | ٧ |
| Input Low Voltage | Logic φ1, φ2 | V _{IL} V _{ILC} | V _{SS} -03 V _{SS} -03 | | V _{SS} +08 V _{SS} +04 | Ņ |
| Input Leakage Current $(V_{in} = 0 \text{ to } 5.25 \text{ V}, V_{CC} = \text{Max})$ $(V_{in} = 0 \text{ to } 5.25 \text{ V}, V_{CC} = 0 \text{ V to } 5.25 \text{ V})$ | Logic ¢ 1, ¢ 2 | I _{In} | - | 1 0 - | 2 5 100 | μА |
| Three-State Input Leakage Current (V _{In} = 0.4 to 2 4 V, V _{CC} = Max) | D0-D7 A0-A15, R/W | ΙΙΖ | _ | 20 | 10 100 | μΑ |
| Output High Voltage (I _{Load} = -205 µA, V _{CC} = Min) (I _{Load} = -145 µA, V _{CC} = Min) (I _{Load} = -100 µA, V _{CC} = Min) | D0-D7 A0-A15, R/W, VMA BA | Voн | V _{SS} +24 V _{SS} +24 V _{SS} +24 | _ | - - - | ٧ |
| Output Low Voltage (I _{Load} = 1.6 mA, V _{CC} = Min) | | VOL | _ | _ | Vss+04 | V |
| Internal Power Dissipation (Measured at $T_A = T_L$) | | PINT | _ | 05 | 10 | W |
| Capacitance (V _{IN} = 0, T _A = 25°C, f = 1.0 MHz) | φ1 φ2 D0-D7 Logic Inputs | C _{in} | _ _ _ _ | 25 45 10 6 5 | 35 70 12 5 10 | pF |
| | A0-A15, R/W, VMA | Cout | - | _ | 12 | pF |

CLOCK TIMING (VCC=50 V, +5%, Vss=0, Ta=Ti to Th unless otherwise noted)

| Characteristic | | Symbol | Min | Тур | Max | Unit |
|---|------------------------------|---------------------------------|-------|-----|------|------|
| Frequency of Operation | MC6800 | | 0.1 | _ | 1.0 | |
| | MC68A00 | f | 0 1 | - | 15 | MHz |
| | MC68B00 | | 0.1 | - 1 | 2.0 | |
| Cycle Time (Figure 1) | MC6800 | | 1 000 | _ | 10 | |
| | MC68A00 | t _{cvc} | 0.666 | - | 10 | μS |
| | MC68B00 | -,- | 0.500 | _ | 10 | ' |
| Clock Pulse Width | φ1, φ2 - MC6800 | | 400 | _ | 9500 | |
| (Measured at V _{CC} – 0.6 V) | $\phi 1, \phi 2 - MC68A00$ | PWøH | 230 | _ | 9500 | ns |
| | ϕ 1, ϕ 2 — MC68B00 | • • • | 180 | - | 9500 | |
| Total φ1 and φ2 Up Time | MC6800 | | 900 | _ | _ | |
| | MC68A00 | tut | 600 | - | _ | ns |
| | MC68B00 | | 440 | - | | L |
| Rise and Fall Time (Measured between VSS+0.4 and VCC | -0.6) | t _r , t _f | _ | _ | 100 | ns |
| Delay Time or Clock Separation (Figure 1) | | | | | | T |
| (Measured at $V_{OV} = V_{SS} + 0.6 \text{ V@t}_f = \text{tf} \le 100 \text{ ns}$) | | td | 0 | - | 9100 | ns |
| (Measured at $V_{OV} = V_{SS} + 1.0 \text{ V@t}_f = \text{tf} \le 35 \text{ ns}$) | | | 0 | - | 9100 | i |



READ/WRITE TIMING (Reference Figures 2 through 6, 8, 9, 11, 12 and 13)

| Characteristic | Symbol | | MC680 | 0 | _ N | 1C68A0 | ю | N | 00 | Unit | |
|---|------------------|-----|-------|------------|-----|--------|------------|-------|-----|------------|----------|
| Characteristic | Symbol | Min | Тур | Max | Min | Тур | Max | Min | Тур | Max | Onne |
| Address Delay | | | | | | | | | | | |
| C = 90 pF C = 30 pF | tAD. | _ | _ | 270 250 | _ | _ | 180 165 | _ | _ | 150 135 | ns |
| | | | | 250 | | _ | 100 | | | 130 | <u> </u> |
| Peripheral Read Access Time $t_{acc} = t_{ut} - (t_{AD} + t_{DSR})$ | tacc | 605 | _ | - | 400 | - | _ | 290 | - | - | ns |
| Data Setup Time (Read) | tDSR | 100 | - | - | 60 | _ | - | 40 | - | - T | ns |
| Input Data Hold Time | tH | 10 | _ | _ | 10 | - | _ | 10 | _ | _ | ns |
| Output Data Hold Time | tH | 10 | 25 | - | 10 | 25 | - | 10 | 25 | - | ns |
| Address Hold Time (Address, R/W, VMA) | t _A H | 30 | 50 | - | 30 | 50 | _ | 30 | 50 | _ | ns |
| Enable High Time for DBE Input | t _{EH} | 450 | _ | - | 280 | _ | - | 220 | _ | _ | ns |
| Data Delay Time (Write) | tDDW | - | _ | 225 | - | _ | 200 | - | _ | 160 | ns |
| Processor Controls | | | | | | | | | | | |
| Processor Control Setup Time | tPCS | 200 | _ | - | 140 | _ | _ | 110 | - | - | 1 |
| Processor Control Rise and Fall Time | tPCr, tPCf | - | - | 100 | - | - | 100 | - | - | 100 | |
| Bus Available Delay | tBA | _ | _ | 250 | _ | - | 165 | - 1 | _ | 135 | l |
| Three-State Enable | tTSE | - | _ | 40 | - 1 | - | 40 | - | - | 40 | ns |
| Three-State Delay | tTSD | - | 1 – | 270 | - | · - | 270 | l – i | - | 220 | ĺ |
| Data Bus Enable Down Time During \$\phi1\$ Up Time | tDBE | 150 | - | - | 120 | - | - | 75 | _ | - | 1 |
| Data Bus Enable Rise and Fall Times | tDBEr, tDBEf | - | | 25 | - | - | 25 | - | - | 25 | |

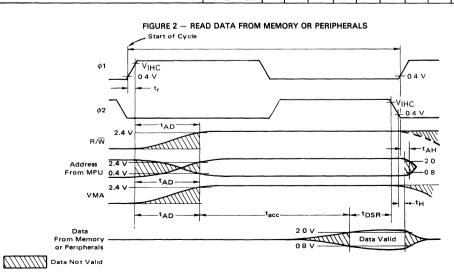


FIGURE 3 — WRITE IN MEMORY OR PERIPHERALS

Start of Cycle

Topic

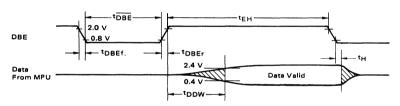




FIGURE 4 - TYPICAL DATA BUS OUTPUT DELAY versus CAPACITIVE LOADING (TDDW) IOH = -205 µA max @ 2.4 V IOL = 1 6 mA max @ 0.4 V VCC = 5.0 V 1A = 25°C 600 500 DELAY TIME (ns) 300 200 100 C_L includes stray capacitance ۰۲ 400 500 100 200 300 CL, LOAD CAPACITANCE (pF)

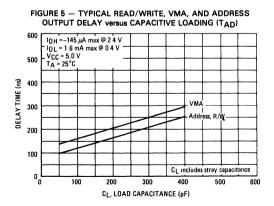
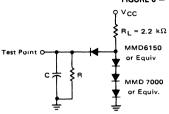


FIGURE 6 - BUS TIMING TEST LOADS



C = 130 pF for D0-D7, E

- = 90 pF for A0-A15, R/W, and VMA (Except t_{AD2})
- = 30 pF for A0-A15, R/ \overline{W} , and VMA (t_{AD2} only)
- = 30 pF for BA

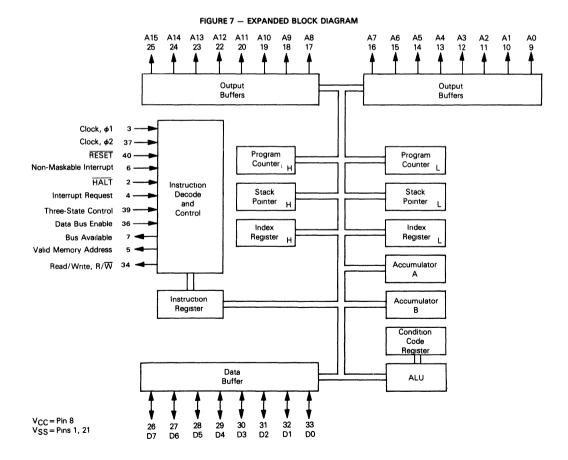
R = 11 7 k Ω for D0-D7

- = 16 5 k Ω for A0-A15, R/ \overline{W} , and VMA
- = 24 k Ω for BA

TEST CONDITIONS

The dynamic test load for the Data Bus is 130 pF and one standard TTL load as shown. The Address, R/W, and VMA outputs are tested under two conditions to allow optimum operation in both buffered and unbuffered systems. The resistor (R) is chosen to insure specified load currents during V_{OH} measurement.

Notice that the Data Bus lines, the Address lines, the Interrupt Request line, and the DBE line are all specified and tested to guarantee 0.4 V of dynamic noise immunity at both "1" and "0" logic levels.



MPU SIGNAL DESCRIPTION

Proper operation of the MPU requires that certain control and timing signals be provided to accomplish specific functions and that other signal lines be monitored to determine the state of the processor.

Clocks Phase One and Phase Two $(\phi 1, \phi 2)$ — Two pins are used for a two-phase non-overlapping clock that runs at the V_{CC} voltage level.

Figure 1 shows the microprocessor clocks. The high level is specified at VI_{IIC} and the low level is specified at VI_{IIC} The allowable clock frequency is specified by f (frequency). The minimum $\phi 1$ and $\phi 2$ high level pulse widths are specified by PW $_{\phi H}$ (pulse width high time). To guarantee the required access time for the peripherals, the clock up time, t $_{ut}$, is specified. Clock separation, t $_{d}$, is measured at a maximum voltage of VOV (overlap voltage). This allows for a multitude of clock variations at the system frequency rate.

Address Bus (A0-A15) — Sixteen pins are used for the address bus. The outputs are three-state bus drivers capable of driving one standard TTL load and 90 pF. When the output is turned off, it is essentially an open circuit. This permits the MPU to be used in DMA applications. Putting TSC in its high state forces the Address bus to go into the three-state mode.

Data Bus (D0-D7) — Eight pins are used for the data bus It is bidirectional, transferring data to and from the memory and peripheral devices. It also has three-state output buffers capable of driving one standard TTL load and 130 pF Data Bus is placed in the three-state mode when DBE is low.

Data Bus Enable (DBE) — This level sensitive input is the three-state control signal for the MPU data bus and will enable the bus drivers when in the high state. This input is TTL compatible; however in normal operation, it would be driven by the phase two clock. During an MPU read cycle, the data bus drivers will be disabled internally. When it is desired that another device control the data bus, such as in Direct Memory Access (DMA) applications, DBE should be held low.

If additional data setup or hold time is required on an MPU write, the DBE down time can be decreased, as shown in Figure 3 (DBE≠¢2). The minimum down time for DBE is tDBE as shown. By skewing DBE with respect to E, data setup or hold time can be increased

Bus Available (BA) — The Bus Available signal will normally be in the low state; when activated, it will go to the high state indicating that the microprocessor has stopped and that the address bus is available. This will occur if the HALT line is in the low state or the processor is in the WAIT state as a result of the execution of a WAIT instruction. At such time, all three-state output drivers will go to their off state and other outputs to their normally inactive level. The processor is removed from the WAIT state by the occurrence of a maskable (mask bit I = 0) or nonmaskable interrupt. This output is capable of driving one standard TTL load and 30 pf. If TSC is in the high state, Bus Available will be low.

Read/Write (R/\overline{W}) — This TTL compatible output signals the peripherals and memory devices wether the MPU is in a

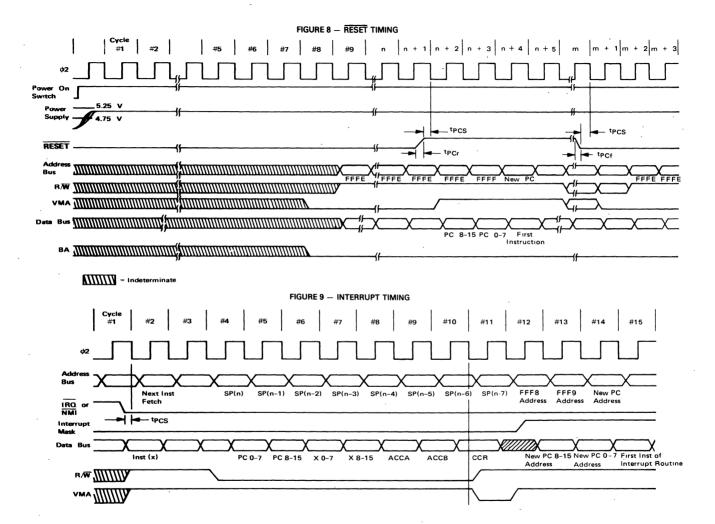
Read (high) or Write (low) state. The normal standby state of this signal is Read (high). Three-State Control going high will turn Read/Write to the off (high impedance) state. Also, when the processor is halted, it will be in the off state. This output is capable of driving one standard TTL load and 90 pF.

RESET — The RESET input is used to reset and start the MPU from a power down condition resulting from a power failure or initial start-up of the processor. This level sensitive input can also be used to reinitialize the machine at any time after start-up.

If a high level is detected in this input, this will signal the MPU to begin the reset sequence. During the reset sequence, the contents of the last two locations (FFFE, FFFF) in memory will be loaded into the Program Counter to point to the beginning of the reset routine. During the reset routine, the interrupt mask bit is set and must be cleared under program control before the MPU can be interrupted by IRQ. While RESET is low (assuming a minimum of 8 clock cycles have occurred) the MPU output signals will be in the following states: VMA = low, BA = low, Data Bus = high impedance, R/\overline{W} = high (read state), and the Address Bus will contain the reset address FFFE. Figure 8 illustrates a power up sequence using the RESET control line. After the power supply reaches 4.75 V, a minimum of eight clock cycles are required for the processor to stabilize in preparation for restarting. During these eight cycles, VMA will be in an indeterminate state so any devices that are enabled by VMA which could accept a false write during this time (such as battery-backed RAM) must be disabled until VMA is forced low after eight cycles RESET can go high asynchronously with the system clock any time after the eighth cycle.

RESET timing is shown in Figure 8. The maximum rise and fall transition times are specified by tp_{Cr} and tp_{Cf} . If RESET is high at tp_{CS} (processor control setup time), as shown in Figure 8, in any given cycle then the restart sequence will begin on the next cycle as shown. The RESET control line may also be used to reinitialize the MPU system at any time during its operation. This is accomplished by pulsing RESET low for the duration of a minimum of three complete $\phi 2$ cycles. The RESET pulse can be completely asynchronous with the MPU system clock and will be recognized during $\phi 2$ if setup time tp_{CS} is met.

Interrupt Request (IRQ) - This level sensitive input requests that an interrupt sequence be generated within the machine. The processor will wait until it completes the current instruction that is being executed before it recognizes the request. At that time, if the interrupt mask bit in the Condition Code Register is not set, the machine will begin an interrupt sequence The Index Register, Program Counter, Accumulators, and Condition Code Register are stored away on the stack. Next, the MPU will respond to the interrupt request by setting the interrupt mask bit high so that no further interrupts may occur. At the end of the cycle, a 16-bit address will be loaded that points to a vectoring address which is located in memory locations FFF8 and FFF9. An address loaded at these locations causes the MPU to branch to an interrupt routine in memory. Interrupt timing is shown in Figure 9.



The HALT line must be in the high state for interrupts to be serviced. Interrupts will be latched internally while HALT is low

The $\overline{\text{IRQ}}$ has a high-impedance pullup device internal to the chip; however, a 3 k Ω external resistor to V_{CC} should be used for wire-OR and optimum control of interrupts.

Non-Maskable Interrupt (NMI) and Wait for Interrupt (WAI) - The MC6800 is capable of handling two types of interrupts. maskable (IRQ) as described earlier, and nonmaskable (NMI) which is an edge sensitive input. IRQ is maskable by the interrupt mask in the condition code register while NMI is not maskable. The handling of these interrupts by the MPU is the same except that each has its own vector address. The behavior of the MPU when interrupted is shown in Figure 9 which details the MPU response to an interrupt while the MPU is executing the control program. The interrupt shown could be either IRQ or NMI and can be asynchronous with respect to $\phi 2$ The interrupt is shown going low at time tpcs in cycle #1 which precedes the first cycle of an instruction (OP code fetch). This instruction is not executed but instead the Program Counter (PC), Index Register (IX), Accumulators (ACCX), and the Condition Code Register (CCR) are pushed onto the stack.

The Interrupt Mask bit is set to prevent further interrupts. The address of the interrupt service routine is then fetched from FFFC, FFFD for an \overline{NM} interrupt and from FFF8, FFF9 for an \overline{IRQ} interrupt. Upon completion of the interrupt service routine, the execution of RTI will pull the PC, IX, ACCX, and CCR off the stack; the Interrupt Mask bit is restored to its condition prior to Interrupts (see Figure 10)

Figure 11 is a similar interrupt sequence, except in this case, a WAIT instruction has been executed in preparation for the interrupt. This technique speeds up the MPU's response to the interrupt because the stacking of the PC, IX, ACCX, and the CCR is already done. While the MPU is waiting for the interrupt, Bus Available will go high indicating the following states of the control lines. VMA is low, and the Address Bus, R/\overline{W} and Data Bus are all in the high impedance state. After the interrupt occurs, it is serviced as previously described.

A 3-10 $k\Omega$ external resistor to VCC should be used for wire-OR and optimum control of interrupts.

MEMORY MAP FOR INTERRUPT VECTORS

| Vec | ctor | Description |
|------|------|------------------------|
| MS | LS | Description |
| FFFE | FFFF | Reset |
| FFFC | FFFD | Non-Maskable Interrupt |
| FFFA | FFFB | Software Interrupt |
| FFF8 | FFF9 | Interrupt Request |

Refer to Figure 10 for program flow for Interrupts

Three-State Control (TSC) — When the level sensitive Three-State Control (TSC) line is a logic "1", the Address Bus and the R/\overline{W} line are placed in a high-impedance state. WMA and BA are forced low when TSC="1" to prevent false reads or writes on any device enabled by VMA. It is necessary to delay program execution while TSC is held high. This is done by insuring that no transitions of ϕ 1 (or ϕ 2) occur during this period. (Logic levels of the clocks are irrelevant so long as they do not change). Since the MPU is a dynamic device, the ϕ 1 clock can be stopped for a maximum

time $PW_{\phi H}$ without destroying data within the MPU TSC then can be used in a short Direct Memory Access (DMA) application.

Figure 12 shows the effect of TSC on the MPU TSC must have its transitions at tTSE (three-state enable) while holding ϕ 1 high and ϕ 2 low as shown. The Address Bus and R/W line will reach the high-impedance state at tTSD (three-state delay), with VMA being forced low. In this example, the Data Bus is also in the high-impedance state while ϕ 2 is being held low since DBE= ϕ 2. At this point in time, a DMA transfer could occur on cycles #3 and #4. When TSC is returned low, the MPU Address and R/W lines return to the bus. Because it is too late in cycle #5 to access memory, this cycle is dead and used for synchronization. Program execution resumes in cycle #6

Valid Memory Address (VMA) — This output indicates to peripheral devices that there is a valid address on the address bus. In normal operation, this signal should be utilized for enabling peripheral interfaces such as the PIA and ACIA This signal is not three-state. One standard TTL load and 90 pF may be directly driven by this active high signal.

HALT — When this level sensitive input is in the low state, all activity in the machine will be halted. This input is level sensitive.

The HALT line provides an input to the MPU to allow control of program execution by an outside source. If HALT is high, the MPU will execute the instructions, if it is low, the MPU will go to a halted or idle mode. A response signal, Bus Available (BA) provides an indication of the current MPU status. When BA is low, the MPU is in the process of executing the control program; if BA is high, the MPU has halted and all internal activity has stopped

When BA is high, the Address Bus, Data Bus, and R/\overline{W} line will be in a high-impedance state, effectively removing the MPU from the system bus VMA is forced low so that the floating system bus will not activate any device on the bus that is enabled by VMA.

While the MPU is halted, all program activity is stopped, and if either an NMI or IRQ interrupt occurs, it will be latched into the MPU and acted on as soon as the MPU is taken out of the halted mode. If a RESET command occurs while the MPU is halted; the following states occur: VMA=low, BA=low, Data Bus=high impedance, R/W=high (read state), and the Address Bus will contain address FFFE as long as RESET is low. As soon as the RESET line goes high, the MPU will go to locations FFFE and FFFF for the address of the reset routine.

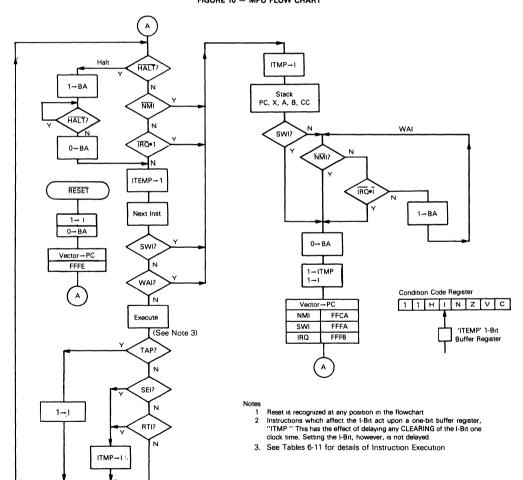
Figure 13 shows the timing relationships involved when halting the MPU. The instruction illustrated is a one byte, 2 cycle instruction such as CLRA. When $\overline{\text{HALT}}$ goes low, the MPU will halt after completing execution of the current instruction. The transition of $\overline{\text{HALT}}$ -must occur tPCS before the trailing edge of $\phi 1$ of the last cycle of an instruction (point A of Figure 13). $\overline{\text{HALT}}$ must not go low any time later than the minmum tPCS specified

The fetch of the $\frac{\hat{OP}}{\text{Co}}$ code by the MPU is the first cycle of the instruction. If HALT had not been low at Point A but went low during $\phi 2$ of that cycle, the MPU would have halted after completion of the following instruction. BA will go high by time tBA (bus available delay time) after the last instruction cycle. At this point in time, VMA is low and R/\overline{W} , Address Bus, and the Data Bus are in the high-impedance state.

To debug programs it is advantageous to step through programs instruction by instruction. To do this, HALT must be brought high for one MPU cycle and then returned low as shown at point B of Figure 13 Again, the transitions of HALT must occur tpcs before the trailing edge of $\phi 1\,$ BA will go low at tbA after the leading edge of the next $\phi 1$, indicating that the Address Bus, Data Bus, VMA and R/W

lines are back on the bus. A single byte, 2 cycle instruction such as LSR is used for this example also. During the first cycle, the instruction Y is fetched from address $M+1.\ BA$ returns high at tBA on the last cycle of the instruction indicating the MPU is off the bus. If instruction Y had been three cycles, the width of the BA low time would have been increased by one cycle

FIGURE 10 - MPU FLOW CHART





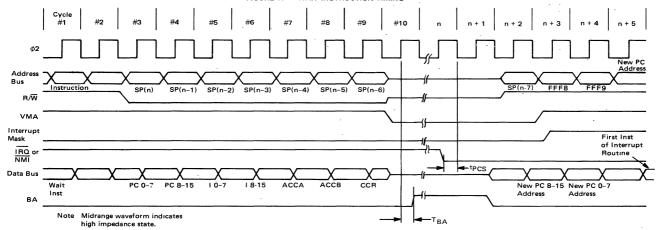
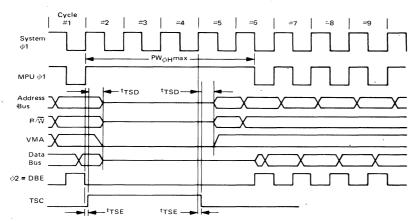


FIGURE 12 - THREE-STATE CONTROL TIMING



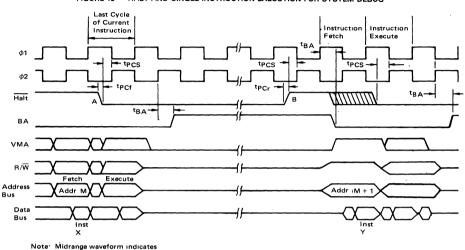


FIGURE 13 - HALT AND SINGLE INSTRUCTION EXECUTION FOR SYSTEM DEBUG

high impedance state.

MPU REGISTERS

The MPU has three 16-bit registers and three 8-bit registers available for use by the programmer (Figure 14)

Program Counter — The program counter is a two byte (16 bits) register that points to the current program address.

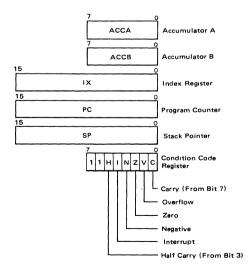
Stack Pointer — The stack ponter is a two byte register that contains the address of the next available location in an external push-down/pop-up stack. This stack is normally a random access Read/Write memory that may have any location (address) that is convenient. In those applications that require storage of information in the stack when power is lost, the stack must be nonvolatile.

Index Register — The index register is a two byte register that is used to store data or a sixteen bit memory address for the Indexed mode of memory addressing

 $\begin{tabular}{lll} \bf Accumulators & - & The MPU contains two 8-bit accumulators that are used to hold operands and results from an arithmetic logic unit (ALU). \end{tabular}$

Condition Code Register — The condition code register indicates the results of an Arithmetic Logic Unit operation: Negative (N), Zero (Z), Overflow (V), Carry from bit 7 (C), and half carry from bit 3 (H). These bits of the Condition Code Register are used as testable conditions for the conditional branch instructions. Bit 4 is the interrupt mask bit (I). The unused bits of the Condition Code Register (b6 and b7) are ones.

FIGURE 14 — PROGRAMMING MODEL OF THE MICROPROCESSING UNIT



MPU INSTRUCTION SET

The MC6800 instructions are described in detail in the M6800 Programming Manual. This Section will provide a brief introduction and discuss their use in developing MC6800 control programs. The MC6800 has a set of 72 different executable source instructions. Included are binary and decimal arithmetic, logical, shift, rotate, load, store, conditional or unconditional branch, interrupt and stack manipulation instructions.

Each of the 72 executable instructions of the source language assembles into 1 to 3 bytes of machine code. The number of bytes depends on the particular instruction and on the addressing mode. (The addressing modes which are available for use with the various executive instructions are discussed later.)

The coding of the first (or only) byte corresponding to an executable instruction is sufficient to identify the instruction and the addressing mode. The hexadecimal equivalents of the binary codes, which result from the translation of the 72 instructions in all valid modes of addressing, are shown in Table 1. There are 197 valid machine codes, 59 of the 256 possible codes being unassigned.

When an instruction translates into two or three bytes of code, the second byte, or the second and third bytes contain(s) an operand, an address, or information from which an address is obtained during execution

Microprocessor instructions are often divided into three general classifications. (1) memory reference, so called because they operate on specific memory locations; (2) operating instructions that function without needing a memory reference; (3) I/O instructions for transferring data between the microprocessor and peripheral devices.

In many instances, the MC6800 performs the same operation on both its internal accumulators and the external memory locations. In addition, the MC6800 interface adapters (PIA and ACIA) allow the MPU to treat peripheral devices exactly like other memory locations, hence, no I/O instructions as such are required. Because of these features, other classifications are more suitable for introducing the MC6800's instruction set (1) Accumulator and memory operations; (2) Program control operations, (3) Condition Code Register operations.

TABLE 1 - HEXADECIMAL VALUES OF MACHINE CODES

| | | | | · | | | | | | | | | | | |
|-----|------|---|-----|----|-----|---|-----|-----|------|---|---------|----|------|-----|---------|
| | _ | | | | | | | 1 | | | | i | | | ļ |
| 00 | | | | 40 | NEG | Α | | 80 | SUB | Α | IMM | CO | SUB | В | IMM |
| 01 | NOP | | | 41 | • | | | 81 | CMP | Α | IMM | C1 | CMP | В | IMM |
| 02 | • | | | 42 | • | | | 82 | SBC | Α | IMM | C2 | SBC | В | IMM |
| 03 | • | | | 43 | COM | Α | | 83 | • | | | СЗ | • | _ | |
| 04 | | | | 44 | LSR | Α | | 84 | AND | Α | IMM | C4 | AND | В | IMM |
| 05 | | | | 45 | | | | 85 | BIT | Â | IMM | C5 | BIT | | |
| 06 | TAP | | | 46 | ROR | Α | | 86 | | Ã | | | | В | IMM |
| 07 | TPA | | | | | | | | LDA | А | IMM | C6 | LDA | В | IMM |
| 08 | | | | 47 | ASR | A | | 87 | | _ | | C7 | | | |
| | INX | | | 48 | ASL | Ą | | 88 | EOR | Α | IMM | C8 | EOR | • в | IMM |
| 09 | DEX | | | 49 | ROL | Α | | 89 | ADC | Α | IMM | C9 | ADC | В | IMM |
| 0A | CLV | | | 4A | DEC | Α | | 8A | ORA | Α | IMM | CA | ORA | В | IMM |
| 0B | SEV | | | 4B | • | | | 8B | ADD | Α | IMM | СВ | ADD | B | IMM |
| 0C | CLC | | | 4C | INC | Α | | 8C | CPX | Α | IMM | cc | | _ | |
| OD | SEC | | | 4D | TST | Α | | 8D | BSR | | REL | CD | | | |
| 0E | CLI | | | 4E | | | | 8E | LDS | | IMM | CE | LDX | | IMM |
| OF | SEI | | | 4F | CLR | Α | | 8F | | | IIVIIVI | CF | LUX | | IIVIIVI |
| 10 | SBA | | | 50 | NEG | ŝ | | 90 | SUB | Α | DID | 00 | CUID | _ | 200 |
| 11 | CBA | | | 51 | MEG | ٥ | | | | | DIR | | SUB | В | DIR |
| 12 | · DA | | | | | | | 91 | CMP | A | DIR | D1 | CMP | В | DIR |
| | | | | 52 | | _ | | 92 | SBC | Α | DIR | D2 | SBC | В | DIR |
| 13 | | | | 53 | COM | В | | 93 | • | | | D3 | • | | 1 |
| 14 | • | | | 54 | LSR | В | | 94 | AND | Α | DIR | D4 | AND | В | DIR |
| 15 | | | | 55 | • | | | 95 | BIT | Α | DIR | D5 | BIT | В | DIR |
| 16 | TAB | | | 56 | ROR | В | | 96 | LDA | Α | DIR | D6 | LDA | B | DIR |
| 17 | TBA | | | 57 | ASR | В | | 97 | STA | Α | DIR | D7 | STA | В | DIR |
| 18 | | | | 58 | ASL | B | | 98 | EOR | Ä | DIR | D8 | EOR | В | DIR |
| 19 | DAA | | | 59 | ROL | В | | 99 | ADC | Â | DIR | D9 | ADC | В | DIR |
| 1A | • | | | 5A | DEC | B | | 9A | ORA | Â | DIR | DA | ORA | В | DIR |
| 1B | ABA | | | 5B | | | | 9B | ADD | Â | DIR | DB | | | |
| 1C | | | | 5C | INC | В | | 9C | CPX | A | DIR | | ADD | В | DIR |
| 10 | | | | 5D | TST | | | | CPX | | DIH | DC | | | |
| 1E | | | | | 151 | В | | 9D | | | | DD | | | 1 |
| 1F | | | | 5E | | _ | | 9E | LDS | | DIR | DE | LDX | | DIR |
| | | | | 5F | CLR | В | | 9F | STS | | DIR | DF | STX | | DIR |
| 20 | BRA | | REL | 60 | NEG | | IND | A0 | SUB | Α | IND | E0 | SUB | В | IND |
| 21 | • | | | 61 | • | | | A1 | CMP | Α | IND | E1 | CMP | В | IND |
| 22 | BHI | | REL | 62 | • | | | A2 | SBC | Α | IND | E2 | SBC | В | IND |
| 23 | BLS | | REL | 63 | COM | | IND | A3 | | | | E3 | • | | |
| 24 | BCC | | REL | 64 | LSR | | IND | A4 | AND | Α | IND | E4 | AND | В | IND |
| 25 | BCS | | REL | 65 | | | | A5 | BIT | A | IND | E5 | BIT | В | IND |
| 26 | BNE | | REL | 66 | ROR | | IND | A6 | LDA | Â | IND | E6 | LDA | | |
| 27 | BEQ | | REL | 67 | ASR | | IND | A7 | STA | Â | IND | | | В | IND |
| 28 | BVC | | REL | 68 | ASL | | IND | | | | | E7 | STA | В | IND |
| 29 | | | | | | | | A8 | EOR | A | IND | E8 | EOR | В | IND |
| | BVS | | REL | 69 | ROL | | IND | A9 | ADC | A | IND | E9 | ADC | В | IND |
| 2A | BPL | | REL | 6A | DEC | | IND | AA | ORA | Α | IND | EA | ORA | В | IND |
| 2B | ВМІ | | REL | 6B | • | | | AB | ADD | Α | IND | EB | ADD | В | IND |
| 2C | BGE | | REL | 6C | INC | | IND | AC | CPX | | IND | EC | • | | - 1 |
| 2D | BLT | | REL | 6D | TST | | IND | AD | JSR | | IND | ED | • | | - 1 |
| 2E | BGT | | REL | 6E | JMP | | IND | AE | LDS | | IND | EE | LDX | | IND |
| 2F | BLE | | REL | 6F | CLR | | IND | AF | STS | | IND | EF | STX | | IND |
| 30 | TSX | | | 70 | NEG | | EXT | BO | SUB | Α | EXT | FO | SUB | В | EXT |
| 31 | INS | | | 71 | | | | B1 | CMP | Â | EXT | F1 | CMP | В | EXT |
| 32 | PUL | Α | | 72 | | | | B2 | SBC | Â | EXT | F2 | SBC | | |
| 33 | PUL | ŝ | | 73 | COM | | EXT | B3 | | ^ | EVI | F3 | SBC | В | EXT |
| 34 | DES | ь | | 74 | | | EVI | | 4410 | | | | | _ | |
| 35 | | | | | LSR | | EXT | B4 | AND | A | EXT | F4 | AND | В | EXT |
| | TXS | | | 75 | | | | B5 | BIT | A | EXT | F5 | BIT | В | EXT |
| 36 | PSH | A | | 76 | ROR | | EXT | B6 | LDA | Α | EXT | F6 | LDA | В | EXT |
| 37 | PSH | В | | 77 | ASR | | EXT | B7 | STA | Α | EXT | F7 | STA | В | EXT |
| 38 | • | | | 78 | ASL | | EXT | B8 | EOR | Α | EXT | F8 | EOR | В | EXT |
| 39 | RTS | | | 79 | ROL | | EXT | B9 | ADC | Α | EXT | F9 | ADC | В | EXT |
| 3A | • | | | 7A | DEC | | EXT | BA | ORA | Ä | EXT | FA | ORA | В | EXT |
| 3B | RTI | | | 7B | | | | BB | ADD | Â | EXT | FB | ADD | В | EXT |
| 3C | | | | 7C | INC | | EXT | BC | CPX | | EXT | FC | | ь | E / 1 |
| 3D | | | | 7D | TST | | EXT | BD | JSR | | EXT | FD | | | - 1 |
| 3E | WAI | | | 7E | JMP | | EXT | BE | | | | | LDV | | |
| 3F | SWI | | | /F | CLR | | EXT | BF | LDS | | EXT | FE | LDX | | EXT |
| 1 3 | 3441 | | | ۱″ | CLN | | EVI | Dr. | STS | | EXT | FF | STX | | EXT |
| | | | | | | | | | | | | | | | |

Notes 1 Addressing Modes

A = Accumulator A
B = Accumulator B
REL = Relative
IND = Indexed
IMM = Immediate
DIR = Direct

2 Unassigned code indicated by " * ".

MC6800 • MC68A00 • MC68B00

TABLE 2 - ACCUMULATOR AND MEMORY OPERATIONS

| OPERATIONS Add Add Acmilus Add with Carry And Bit Test Clear Compare | MNEMONIC ADDA ADDB ABA ADCA ADCB ANDA ANDB BITA BITB CLR CLRA CLRB CMPA | 0P 8B CB 89 C9 84 C4 85 C5 | 2 2 2 2 2 2 2 2 2 | 2 2 2 2 2 2 2 2 2 | 98 08 99 99 94 94 | 3 3 3 3 | 2 2 2 2 | OP AB EB A9 E9 | 5 5 | | | XTN - 4 4 | 3 | IM OP | PLIE | D = | BOOLEAN/ARITHMETIC OPERATION (All register labels refer to contents) | 5 H | 4 | 3 N | 2 1 | 0 / C |
|--|--|--|---|---|----------------------------------|------------------|------------------|----------------|--------|---|----------|--------------------|---|----------|------|--------|--|--------|-----|--------|--------------|--------------|
| Add Acmitrs Add with Carry And Bit Test Clear | ADDA ADOB ABA ADCA ADCB ANDA ANDB BITA BITB CLR CLRA CLRB | 88 CB 89 C9 84 C4 | 2 2 2 2 2 2 2 2 | 2 2 2 2 2 2 | 98 DB 99 D9 94 D4 | 3 3 3 | 2 2 2 | OP AB EB | 5 | 2 | вв | 4 | 3 | OP | ` | = | refer to contents) | H | 1 | N | z۱ | / C |
| Add Acmitrs Add with Carry And Bit Test Clear | ADDA ADOB ABA ADCA ADCB ANDA ANDB BITA BITB CLR CLRA CLRB | 89 69 84 64 85 | 2 2 2 2 2 2 | 2 2 2 2 2 | DB 99 D9 94 D4 | 3 3 3 | 2 2 2 | AB EB | 5 | 2 | вв | | | | | | | 1,1 | | , 1 | ,† | + |
| Add with Carry And Bit Test Clear | ABA ADCA ADCB ANDA ANDB BITA BITB CLR CLRA CLRB | 89 C9 84 C4 85 | 2 2 2 2 2 | 2 2 2 2 | 99 D9 94 D4 | 3 | 2 2 2 | A9 | 5 | | FB | 4 | | | | | A+M -A | | | | | i l i |
| Add with Carry And Bit Test Clear | ADCA ADCB ANDA ANDB BITA BITB CLR CLRA CLRB | C9 84 C4 85 | 2 2 2 2 | 2 2 2 | D9 94 D4 | 3 | 2 | | 5 | | | 7 | 3 | | | | B + M - B | | • | 1 | t | 1 1 |
| And Bit Test Clear | ADCB ANDA ANDB BITA BITB CLR CLRA CLRB | C9 84 C4 85 | 2 2 2 2 | 2 2 2 | D9 94 D4 | 3 | 2 | | 5 | | | | _ | 18 | 2 | 1 | A + B · A | | | | | 1 1 |
| Bit Test Clear | ANDA ANDB BITA BITB CLR CLRA CLRA | 84 C4 85 | 2 2 2 | 2 | 94 D4 | | | | 5 | 2 | B9 F9 | 4 | 3 | | | | A + M + C · A B + M + C · B | | | | | : : |
| Clear | ANDB BITA BITB CLR CLRA CLRB | 85 | 2 | 2 | | | 2 | A4 | 5 | 2 | 84 | 4 | 3 | l | | | A M · A | | - 1 | | | |
| Clear | BITB CLR CLRA CLRB | | | 2 | | 3 | 2 | E4 | 5 | 2 | F4 | 4 | 3 | | | | B · M · B | • | • | 1 | : | |
| | CLR CLRA CLRB | C5 | 2 | | 95 | 3 | 2 | A5 | 5 | 2 | B5 | 4 | 3 | | | | A·M | • | - 1 | ٠, | | ۹ • |
| | CLRA CLRB | 1 | | 2 | 05 | 3 | 2 | 65 6F | 5 7 | 2 | F5 7F | 6 | 3 | | | | B M | | - 1 | ٠, | 1 1 | |
| Compare | CLRB | | | | | | | br. | ' | - |) ′r | | 3 | ΔF | 2 | 1 | 00 · M | | | | | RR |
| Compare | CMDA | 1 | | | | | | | | | | | | 5F | 2 | i | 00 · B | | | | | R |
| | | 81 | 2 | 2 | 91 | 3 | 2 | A1 | 5 | 2 | В1 | 4 | 3 | | | | A M | | • | 1 | ţ. | 1 1 |
| | CMPB | C1 | 2 | 2 | DI | 3 | 2 | E١ | 5 | 2 | F1 | 4 | 3 | | | | B - M | 1 . 1 | | | | 1 1 |
| Compare Acmitrs Complement, 1's | CBA COM | 1 | | | | | | 63 | 7 | 2 | 73 | 6 | 3 | 11 | 2 | 1 | A - B M - M | | | | | t t |
| Complement, 1's | COMA | | | | | | | 63 | ' | - | /3 | 0 | 3 | 43 | 2 | 1 | M → M | | | | : [| |
| | COMB | | | | | | | | | | | | | 53 | 2 | 1 | B→B | | • | | : 1 | |
| Complement, 2's | NEG | 1 | | | | | | 60 | 7 | 2 | 70 | 6 | 3 | | | | 00 - M → M | | • | 1 | 1 0 | DIQ |
| (Negate) | NEGA | 1 | | | | | | | | | | | | 40 | 2 | 1 | 00 - A → A | | | | | 02 |
| Decimal Adjust, A | NEGB DAA | 1 | | | | | | | | | | | | 50 19 | 2 | 1 | 00 - B · B | | | | 1 0 | |
| Decimal Adjust, A | UAA | | | | | | | | | | | | | 19 | 2 | 1 | Converts Binary Add of BCD Characters into BCD Format | 1 | • | 1 | 1 | 3 |
| Decrement | DEC | | | | | | | 6A | 7 | 2 | 7A | 6 | 3 | | | | M - 1 → M | | | 1 | 1 4 | ١. |
| | DECA | ì | | | | | | | | | | | | 4A | 2 | 1 | A - 1 → A | | | | | |
| | DECB | 1 | | | | | | | | | | | | 5A | 2 | 1 | B - 1 → B | | | 1 | 1 4 | |
| Exclusive OR | EORA | 88 | 2 | 2 | 98 | 3 | 2 | A8 | 5 | 2 | B8 | 4 | 3 | | | | A⊕M → A | | | | : F | |
| Ingramone | EORB | C8 | 2 | 2 | D8 | 3 | 2 | E8 | 5 | 2 | F8 | 4 | 3 | | | | B⊕M → B | | | | 1 | |
| Increment | INC | Ì | | | | | | 6C | 7 | 2 | 7C | 6 | 3 | 4C | 2 | 1 | M + 1 → M A + 1 → A | | | | : 0 | 9: |
| | INCB | 1 | | | | | | | | | | | | 5C | 2 | i | B+1 ·B | | | | | ١. |
| Load Acmitr | LDAA | 86 | 2 | 2 | 96 | 3 | 2 | A6 | 5 | 2 | B6 | 4 | 3 | | | | M → A | • | | | 1 6 | |
| | LDAB | C6 | 2 | 2 | 06 | 3 | 2 | E6 | 5 | 2 | F6 | 4 | 3 | | | | M *B | • | • | 1 | 1 1 | ≀ • |
| Or, Inclusive | ORAA | 8A | 2 | 2 | 9A | 3 | 2 | AA | 5 | 2 | BA | 4 | 3 | l | | | A + M → A | | | | 1 1 | |
| Push Data | ORAB PSHA | CA | 2 | 2 | DA | 3 | 2 | EA | 5 | 2 | FA | 4 | 3 | | | | B+M→B | | | | 1 1 | |
| rusii Data | PSHB | | | | | | | | | | | | | 36 37 | 4 | 1 | $A \rightarrow M_{SP}, SP - 1 \rightarrow SP$ $B \rightarrow M_{SP}, SP - 1 \rightarrow SP$ | | | | | |
| Pull Data | PULA | | | | | | | | | | | | | 32 | 4 | i | SP + 1 → SP, MSP → A | | | | | |
| | PULB | | | | | | | | | | 1 | | | 33 | 4 | 1 | SP + 1 → SP, M _{SP} → B | | | | • | |
| Rotate Left | ROL | 1 | | | | | | 69 | 7 | 2 | 79 | 6 | 3 | | _ | | M) [| | | | : 0 | 1 |
| | ROLA ROLB | 1 | | | | | | | | | | | | 49 59 | 2 | 1 | A C - 07 - 60 | | | | : 0 : 0 | 1 2 1 |
| Rotate Right | ROR | 1 | | | | | | 66 | 7 | 2 | 76 | 6 | 3 | 59 | 2 | ' | M) | | | | ‡ (d | 3 : |
| | RORA | | | | | | | | | - | ' | ٠ | ٠ | 46 | 2 | 1 | A -0 - 00000 | | | | 10 | i k |
| | RORB | 1 | | | | | | | | | | | | 56 | 2 | 1 | в) с 67 — 60 | | | | ‡ Q | ‡ 1 |
| Shift Left, Arithmetic | ASL. | 1 | | | | | | 68 | 7 | 2 | 78 | 6 | 3 | | | | M | | | | 1 0 | 1 (6 |
| 1 | ASLA | | | | | | | İ | | | 1 | | | 48 | 2 | 1 | A C b7 b0 | | | | | |
| Shift Right, Arithmetic | ASLB ASR |] | | | | | | 6/ | 7 | 2 | 77 | 6 | 3 | 58 | 2 | 1 : | B C b7 b0 | | | | | 1 (G |
| | ASRA | | | | | | | • | , | 1 | l " | ٠ | • | 47 | 2 | 1 | A} | | | | ‡ (d | 5 : |
| | ASRB | ĺ | | | | | | | | | 1 | | | 57 | 2 | 1 | B) b7 b0 C | | | | 10 | 1 |
| Shift Right, Logic | LSR | | | | | | | 64 | 7 | 2 | 74 | 6 | 3 | | | | M] | | | | ‡ [(| 1 |
| | LSRA | | | | | | | | | | | | | 44 | 2 | 1 | A 0 - 0 - 0 - 0 - 0 - 0 - 0 - 0 - 0 - 0 | | | | ‡ Q | \$ G |
| Store Acmitr | LSRB | | | | 97 | | , | A7 | c | , | 0.7 | | , | 54 | 2 | 1 | 6) " | | | | | 1 |
| OLUTE ACTIVIT | STAA STAB | 1 | | | 97 D7 | 4 | 2 | A7 E7 | 6 | 2 | B7 F7 | 5 | 3 | | | | A → M B → M | | : | | | 1 |
| Subtract | SUBA | 80 | 2 | 2 | 90 | 3 | 2 | A0 | 5 | 2 | 80 | 4 | 3 | | | | A - M → A | | | | | 1 |
| | SUBB | CO | 2 | 2 | 00 | 3 | 2 | EO | 5 | 2 | FO | 4 | 3 | | | | B – M → B | • | • | 1 | ‡ : | t t |
| Subtract Acmitrs | SBA | | | | | | | | _ | | | | | 10 | 2 | 1 | A - B → A | | • | | | 1 1 |
| Subtr with Carry | SBCA | 82 | 2 | 2 | 92 | 3 | 2 | A2 | 5 | 2 | B2 | 4 | 3 | | | | A - M - C → A | | | | | : : |
| Transfer Acmitrs | SBCB TAB | C2 | 2 | 2 | D2 | 3 | 2 | E2 | 5 | 2 | F2 | 4 | 3 | 16 | 2 | 1 | B - M - C → B A → B | | : | | ‡ ; | : |
| Mellings | TBA | 1 | | | | | | | | | | | | 17 | 2 | i | 8 → A | | | | 1 | |
| Test, Zero or Minus | TST | 1 | | | | | | 6D | 7 | 2 | 70 | 6 | 3 | | - | | M - 00 | | | | t i | |
| | TSTA | | | | | | | | | | | | | 4D | 2 | 1 | A – 00 | | • | 1 | | R |
| | TSTB | <u> </u> | | | | | | | | | L | | | 5D | 2 | 1 | B - 00 | ++ | -+ | - | - | R |
| | | | | | | | | | | | | | | | | | | H | 1 | N | z١ | / C |

LEGEND

- Operation Code (Hexadecimal),
- Number of MPU Cycles, Number of Program Bytes,
- Arithmetic Plus,
- Arithmetic Minus,
- Boolean AND,
- MSP Contents of memory location pointed to be Stack Pointer,
- Boolean Inclusive OR,
- Boolean Exclusive OR, Complement of M,
- Bit = Zero, Byte = Zero,

00

CONDITION CODE SYMBOLS

- Half carry from bit 3,
- Interrupt mask
- Negative (sign bit) Zero (byte)
- Overflow, 2's complement Carry from bit 7
- Reset Always
- Set Always
- Test and set if true, cleared otherwise Not Affected

CONDITION CODE REGISTER NOTES:

(Bit set if test is true and cleared otherwise)

- (Bit V) Test Result = 10000000?
- (Bit C) Test Result = 00000000?
 - (Bit C) Test Decimal value of most significant BCD
 - Character greater than nine? (Not cleared if previously set)
- (Bit V) Test Operand = 10000000 prior to execution?
- (Bit V) Test Operand = 01111111 prior to execution? (Bit V) Test Set equal to result of N⊕C after shift has occurred 6

 $[\]textbf{Note} - \textbf{Accumulator addressing mode instructions are included in the column for IMPLIED addressing}$

PROGRAM CONTROL OPERATIONS

Program Control operation can be subdivided into two categories (1) Index Register/Stack Pointer instructions, (2) Jump and Branch operations.

Index Register/Stack Pointer Operations

The instructions for direct operation on the MPU's Index Register and Stack Pointer are summarized in Table 3. Decrement (DEX, DES), increment (INX, INS), load (LDX, LDS), and store (STX, STS) instructions are provided for both. The Compare instruction, CPX, can be used to compare the Index Register to a 16-bit value and update the Condition Code Register accordingly.

The TSX instruction causes the Index Register to be loaded with the address of the last data byte put onto the "stack". The TXS instruction loads the Stack Pointer with a value equal to one less than the current contents of the Index Register. This causes the next byte to be pulled from the "stack" to come from the location indicated by the Index Register. The utility of these two instructions can be clarified by describing the "stack" concept relative to the M6800 system.

The "stack" can be thought of as a sequential list of data stored in the MPU's read/write memory. The Stack Pointer contains a 16-bit memory address that is used to access the list from one end on a last-in-first-out (LIFO) basis in contrast to the random access mode used by the MPU's other addressing modes.

The MC6800 instruction set and interrupt structure allow extensive use of the stack concept for efficient handling of data movement, subroutines and interrupts. The instructions can be used to establish one or more "stacks" anywhere in read/write memory. Stack length is limited only by the amount of memory that is made available.

Operation of the Stack Pointer with the Push and Pull instructions is illustrated in Figures 15 and 16. The Push instruction (PSHA) causes the contents of the indicated accumulator (A in this example) to be stored in memory at the location indicated by the Stack Pointer. The Stack Pointer is automatically decremented by one following the storage operation and is "pointing" to the next empty stack location. The Pull instruction (PULA or PULB) causes the last byte stacked to be loaded into the appropriate accumulator. The

Stack Pointer is automatically incremented by one just prior to the data transfer so that it will point to the last byte stacked rather than the next empty location. Note that the PULL instruction does not "remove" the data from memory, in the example, 1A is still in location (m+1) following execution of PULA. A subsequent PUSH instruction would overwrite that location with the new "pushed" data

Execution of the Branch to Subroutine (BSR) and Jump to Subroutine (JSR) instructions cause a return address to be saved on the stack as shown in Figures 18 through 20. The stack is decremented after each byte of the return address is pushed onto the stack. For both of these instructions, the return address is the memory location following the bytes of code that correspond to the BSR and JSR instruction. The code required for BSR or JSR may be either two or three bytes, depending on whether the JSR is in the indexed (two bytes) or the extended (three bytes) addressing mode Before it is stacked, the Program Counter is automatically incremented the correct number of times to be pointing at the location of the next instruction. The Return from Subroutine Instruction, RTS, causes the return address to be retrieved and loaded into the Program Counter as shown in Figure 21.

There are several operations that cause the status of the MPU to be saved on the stack. The Software Interrupt (SWI) and Wait for Interrupt (WAI) instructions as well as the maskable (\$\overline{IRQ}\$) and non-maskable (\$\overline{IRQ}\$) hardware interrupts all cause the MPU's internal registers (except for the Stack Pointer itself) to be stacked as shown in Figure 23 MPU status is restored by the Return from Interrupt, RTI, as shown in Figure 22

Jump and Branch Operation

The Jump and Branch instructions are summarized in Table 4. These instructions are used to control the transfer or operation from one point to another in the control program

The No Operation instruction, NOP, while included here, is a jump operation in a very limited sense. Its only effect is to increment the Program Counter by one. It is useful during program development as a "stand-in" for some other instruction that is to be determined during debug. It is also used for equalizing the execution time through alternate paths in a control program.

TABLE 3 — INDEX REGISTER AND STACK POINTER INSTRUCTIONS

| | | | | | | | | | | | | | | | | | | CO | ND | CO | DE | RE | G |
|-----------------------|----------|----|-----|---|-----|-----|-----|----|-----|---|----|-----|---|----|------|---|---|----|----|----|-----|----|---|
| | | 10 | име | D | D | IRE | CT. | 11 | NDE | X | E | XTN | D | IM | PLIE | D | | 5 | 4 | 3 | 2 | 1 | 0 |
| POINTER OPERATIONS | MNEMONIC | OP | ~ | # | OP | ~ | # | OP | ~ | # | OP | ~ | # | OP | ~ | # | BOOLEAN/ARITHMETIC OPERATION | Н | 1 | N | z | v | С |
| Compare Index Reg | CPX | 8C | 3 | 3 | 90 | 4 | 2 | AC | 6 | 2 | BC | 5 | 3 | | | | XH - M, XL - (M + 1) | • | • | 1 | : 1 | 2 | • |
| Decrement Index Reg | DEX | | | | 1 | | 1 | | | | | | | 09 | 4 | 1 | X – 1 → X | | • | • | 1 | • | • |
| Decrement Stack Pntr | DES | | | l | | | | | | | | | | 34 | 4 | 1 | $SP - 1 \rightarrow SP$ | | • | • | • | • | • |
| Increment Index Reg | INX | | | | | | 1 | | | | | | | 08 | 4 | 1 | X + 1 → X | • | • | • | 1 | • | • |
| Increment Stack Potr | INS | | 1 | 1 | 1 | | | | | | | | | 31 | 4 | 1 | SP + 1 → SP | | • | • | • | • | • |
| Load Index Reg | LDX · | CE | 3 | 3 | DE | 4 | 2 | EE | 6 | 2 | FE | 5 | 3 | | | | $M \rightarrow X_H$, $(M + 1) \rightarrow X_L$ | | • | 3 | | R | • |
| Load Stack Pntr | LOS | 8E | 3 | 3 | 9E | 4 | 2 | ΑE | 6 | 2 | BE | 5 | 3 | | | | $M \rightarrow SP_H$, $(M + 1) \rightarrow SP_L$ | | • | 3 | : | R | • |
| Store Index Reg | STX | | | | ·DF | 5 | 2 | EF | 7 | 2 | FF | 6 | 3 | | | | $X_H \rightarrow M, X_L \rightarrow (M+1)$ | | • | 3 | : | R | • |
| Store Stack Pntr | STS | | ĺ | l | 9F | 5 | 2 | AF | 7 | 2 | BF | 6 | 3 | | | | $SP_H \rightarrow M$, $SP_L \rightarrow (M + 1)$ | | • | 3 | ; | R | • |
| Indx Reg → Stack Pntr | TXS | | | | | | | ł | | | | | | 35 | 4 | 1 | X ~ 1 → SP | • | • | • | • | • | • |
| Stack Pntr → Indx Reg | TSX | l | | l | 1 | | | 1 | | | 1 | | | 30 | 4 | 1 | SP + 1 - X | • | • | • | • | • | • |

⁽Bit N) Test Sign bit of most significant (MS) byte of result = 1?

⁽Bit V) Test 2's complement overflow from subtraction of ms bytes?

⁽Bit N) Test Result less than zero? (Bit 15 = 1)

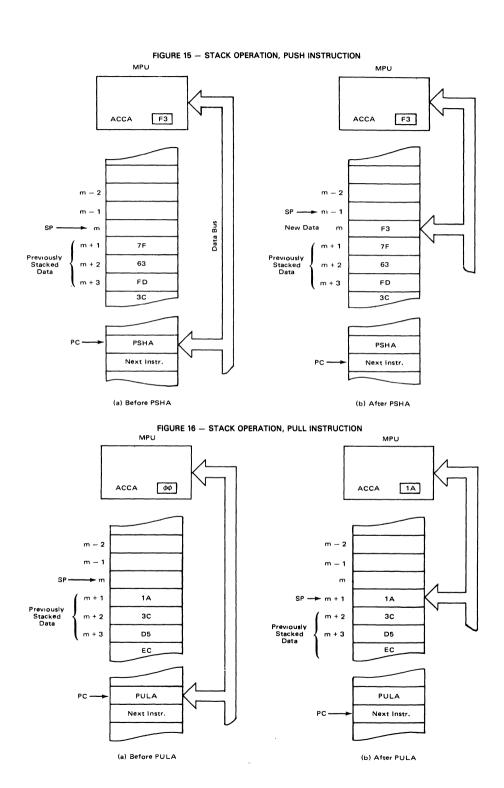


TABLE 4 - JUMP AND BRANCH INSTRUCTIONS

| | | | | | | | | | | | | | | _ | | | CON | D C | ODE | REG | |
|--------------------------|----------|-----|------|----|-----|-----|---|----|-----|----|----|-------|----|-----|-------------------------|---|-----|-----|------|-----|---|
| | | RE | LATI | VE | ı | NDE | X | Ε | XTN | ID | IN | IPLIE | ED | | | 5 | 4 | 3 | 2 | 1 | 0 |
| OPERATIONS | MNEMONIC | OP | ~ | # | OP | ~ | # | OP | ~ | # | OP | ~ | # | 1 | BRANCH TEST | Н | 1 | N | Z | ٧ | C |
| Branch Always | BRA | 20 | 4 | 2 | | | | | | | | | T | | None | • | • | • | • | • | • |
| Branch If Carry Clear | BCC | 24 | 4 | 2 | | | | | | | | | - | l | C = 0 | • | • | • | • | • | • |
| Branch If Carry Set | BCS | 25 | 4 | 2 | 1 | | | | | | | | 1 | 1 | C = 1 | • | • | • | • | • | • |
| Branch If = Zero | BEQ | 27 | 4 | 2 | } | | 1 | 1 | | 1 | | | | 1 | Z = 1 | • | • | • | | • | • |
| Branch If ≥ Zero | BGE | 2 C | 4 | 2 | | | 1 | | | | 1 | | | 1 | N ⊕ V = 0 | • | • | • | • | • | • |
| Branch If > Zero | BGT | 2E | 4 | 2 | | | 1 | | | | | | | | $Z + (N \oplus V) = 0$ | • | • | | | • | • |
| Branch If Higher | BHI | 22 | 4 | 2 | | | | 1 | | | ĺ | | | 1 | C + Z = 0 | • | • | • | • | • | |
| Branch If ≤ Zero | BLE | 2F | 4 | 2 | | | | | | 1 | 1 | | | 1 | Z + (N | | • | | • | • | |
| Branch If Lower Or Same | BLS | 23 | 4 | 2 | | | | | | 1 | 1 | | | 1 | C + Z = 1 | | • | | • | • | |
| Branch If < Zero | BLT | 2D | 4 | 2 | | | | | | | | | 1 | | N ⊕ V = 1 | | | • | • | • | |
| Branch If Minus | BMI | 2B | 4 | 2 | | | | | | 1 | 1 | | | 1 | N = 1 | • | • | • | • | • | • |
| Branch If Not Equal Zero | BNE | 26 | 4 | 2 | | | | | | 1 | } | | 1 | | Z = 0 | | • | • | | | |
| Branch If Overflow Clear | BVC | 28 | 4 | 2 | | | | | | | | | 1 | 1 | V = 0 | • | • | • | • | • | • |
| Branch If Overflow Set | BVS | 29 | 4 | 2 | | | | | | | | | | 1 | V = 1 | | • | | • | • | |
| Branch If Plus | BPL | 2A | 4 | 2 | | | | ĺ | | 1 | 1 | | 1 | 1 | N = 0 | | • | • | • | | |
| Branch To Subroutine | BSR | 8D | 8 | 2 | | | | | | | l | | | | | • | | | | • | |
| Jump | JMP | | | | 6E | 4 | 2 | 7E | 3 | 3 | | | 1 | \ } | See Special Operations | • | • | • | • | • | • |
| Jump To Subroutine | JSR | | | | AD | 8 | 2 | BD | 9 | 3 | | | - | 1 | | • | | • | • | • | • |
| No Operation | NOP | | | | | | | | | 1 | 01 | 2 | 1 | ' | Advances Prog Cntr Only | • | | • | | • | |
| Return From Interrupt | RTI | | | | | | | | | | 3B | 10 | 1 | 1 | | | | - (| 1) - | | |
| Return From Subroutine | RTS | | | | | | | | | l | 39 | 5 | 1 |) | | • | | • | Ĭ • | | |
| Software Interrupt | SWI | | | | i i | | | | | | 3F | 12 | 1 | } | See Special Operations | | • | • | | • | |
| Wait for Interrupt * | WAI | | | | | | | | | | 3E | 9 | 1 | | | • | 2 | • | • | • | • |

^{*}WAI puts Address Bus, R/W, and Data Bus in the three-state mode while VMA is held low

- (All) Load Condition Code Register from Stack (See Special Operations)
- (Bit 1) Set when interrupt occurs. If previously set, a Non-Maskable Interrupt is required to exit the wait state

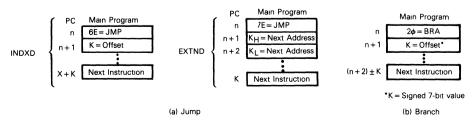
Execution of the Jump Instruction, JMP, and Branch Always, BRA, affects program flow as shown in Figure 17. When the MPU encounters the Jump (Indexed) instruction, it adds the offset to the value in the Index Register and uses the result as the address of the next instruction to be executed. In the extended addressing mode, the address of the next instruction to be executed is fetched from the two locations immediately following the JMP instruction. The Branch Always (BRA) instruction is similar to the JMP (extended) instruction except that the relative addressing mode applies and the branch is limited to the range within -125 or +127 bytes of the branch instruction itself. The opcode for the BRA instruction requires one less byte than JMP (extended) but takes one more cycle to execute

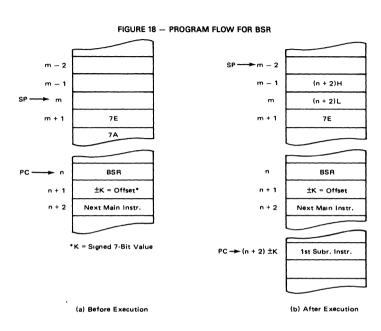
The effect on program flow for the Jump to Subroutine (JSR) and Branch to Subroutine (BSR) is shown in Figures 18 through 20 Note that the Program Counter is properly incremented to be pointing at the coriect return address before it is stacked Operation of the Branch to Subroutine and Jump to Subroutine (extended) instruction is similar except for the range. The BSR instruction requires less opcode than JSR (2 bytes versus 3 bytes) and also executes one cy-

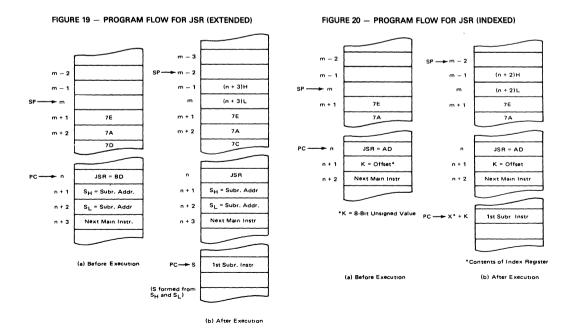
cle faster than JSR. The Return from Subroutine, RTS, is used as the end of a subroutine to return to the main program as indicated in Figure 21.

The effect of executing the Software Interrupt, SWI, and the Wait for Interrupt, WAI, and their relationship to the hardware interrupts is shown in Figure 22 SWI causes the MPU contents to be stacked and then fetches the starting address of the interrupt routine from the memory locations that respond to the addresses FFFA and FFFB. Note that as in the case of the subroutine instructions, the Program Counter is incremented to point at the correct return address before being stacked. The Return from Interrupt instruction. RTI, (Figure 22) is used at the end of an interrupt routine to restore control to the main program. The SWI instruction is useful for inserting break points in the control program, that is, it can be used to stop operation and put the MPU registers in memory where they can be examined. The WAI instruction is used to decrease the time required to service a hardware interrupt, it stacks the MPU contents and then waits for the interrupt to occur, effectively removing the stacking time from a hardware interrupt sequence.

FIGURE 17 - PROGRAM FLOW FOR JUMP AND BRANCH INSTRUCTIONS







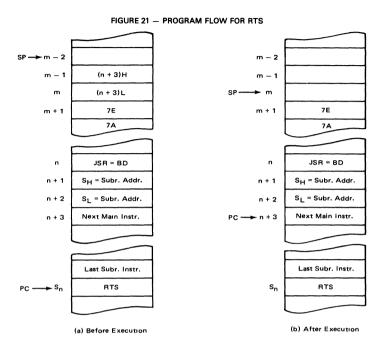
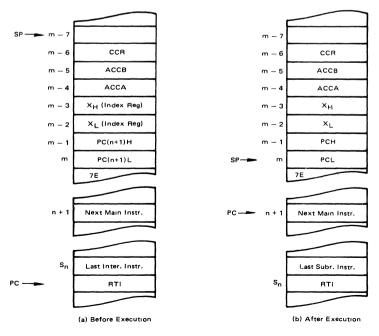


FIGURE 22 - PROGRAM FLOW FOR RTI



Hardware Interrupt or Wait For Software Interrupt Interrupt Non-Maskable Interrupt (NMI) Main Program Main Program Main Program 3F = SWI 3E = WAI Next Main Instr Next Main Instr. Last Prog Byte Int NO YES (CCR 4) Yes Continue Main Prog Next Main Instr Stack → m - 7 Condition Code Stack MPU Acmitr. B Register Contents Acmitr A Index Register (X_H) m - 3m – 2 Index Register (X1) m - 1 PC(n + 1)H PC(n + 1)L m SWI HDWR WAI NMI Restart INT Yes Hdwr Int Int. Rea NMI Mask Set? Wait Loop (CCR 4) FFFC FFFD FFFA FFF8 FFF9 FFFB Interrupt Memory Assignment¹ Set Interrupt Mask (CCR 4) FFF8 IRQ MS LS FFF9 IRQ MS FFFA SWI First Instr Load Interrupt Addr Formed LS FFFB SWI By Fetching Vector Into MS FFFC NMI 2-Bytes From Per Mem Program Counter LS NMI FFFD Assign. FFFE Reset MS Reset Interrupt Program NOTE: MS = Most Significant Address Byte, 1st Interrupt Instr. LS = Least Significant Address Byte;

FIGURE 23 - PROGRAM FLOW FOR INTERRUPTS

FIGURE 24 - CONDITIONAL BRANCH INSTRUCTIONS

```
N = 1 :
                                          7 = 1
RMI .
                               REO .
BPL :
           N = \phi,
                               BNE .
                                          Z = 0 :
BVC ·
                               BCC ·
                                          C = \phi.
BVS :
                               BCS :
           C + Z = 6 :
                                          N + V = 1 :
BLS :
                               RGF ·
                                          N \oplus V = \phi
                          Z+(N+V)=1.
               RIF .
               BGT :
                          Z + (N \oplus V) = \phi
```

The conditional branch instructions, Figure 24, consists of seven pairs of complementary instructions. They are used to test the results of the preceding operation and either continue with the next instruction in sequence (test fails) or cause a branch to another point in the program (test succeeds)

Four of the pairs are used for simple tests of status bits N, Z, V, and C:

- 1. Branch on Minus (BMI) and Branch On Plus (BPL) tests the sign bit, N, to determine if the previous result was negative or positive, respectively.
- 2. Branch On Equal (BEQ) and Branch On Not Equal (BNE) are used to test the zero status bit, Z, to determine whether or not the result of the previous operation was equal to zero. These two instructions are useful following a Compare (CMP) instruction to test for equality between an accumulator and the operand. They are also used following the Bit Test (BIT) to determine whether or not the same bit positions are set in an accumulator and the operand.
- 3. Branch On Overflow Clear (BVC) and Branch On Overflow Set (BVS) tests the state of the V bit to determine if the previous operation caused an arithmetic overflow.
- 4. Branch On Carry Clear (BCC) and Branch On Carry Set (BCS) tests the state of the C bit to determine if the previous operation caused a carry to occur. BCC and BCS are useful

for testing relative magnitude when the values being tested are regarded as unsigned binary numbers, that is, the values are in the range 00 (lowest) to FF (highest). BCC following a comparison (CMP) will cause a branch if the (unsigned) value in the accumulator is higher than or the same as the value of the operand. Conversely, BCS will cause a branch if the accumulator value is lower than the operand

The fifth complementary pair, Branch On Higher (BHI) and Branch On Lower or Same (BLS) are, in a sense, complements to BCC and BCS. BHI tests for both C and Z=0; if used following a CMP, it will cause a branch if the value in the accumulator is higher than the operand Conversely, BLS will cause a branch if the unsigned binary value in the accumulator is lower than or the same as the operand.

The remaining two pairs are useful in testing results of operations in which the values are regarded as signed two's complement numbers. This differs from the unsigned binary case in the following sense: in unsigned, the orientation inhigher or lower; in signed two's complement, the comparison is between larger or smaller where the range of values is between – 128 and + 127.

Branch On Less Than Zero (BLT) and Branch On Greater Than Or Equal Zero (BGE) test the status bits for N Φ V = 1 and N Φ V = 0, respectively BLT will always cause a branch following an operation in which two negative numbers were added. In addition, it will cause a branch following a CMP in which the value in the accumulator was negative and the operand was positive. BLT will never cause a branch following a CMP in which the accumulator value was positive and the operand negative. BGE, the complement to BLT, will cause a branch following operations in which two positive values were added or in which the result was zero.

The last pair, Branch On Less Than Or Equal Zero (BLE) and Branch On Greater Than Zero (BGT) test the status bits for Z \oplus (N+V) = 1 and Z \oplus (N+V) = 0, respectively. The action of BLE is identical to that for BLT except that a branch will also occur if the result of the previous result was zero. Conversely, BGT is similar to BGE except that no branch will occur following a zero result.

CONDITION CODE REGISTER OPERATIONS

The Condition Code Register (CCR) is a 6-bit register within the MPU that is useful in controlling program flow during system operation. The bits are defined in Figure 25.

The instructions shown in Table 5 are available to the user for direct manipulation of the CCR.

A CLI-WAI instruction sequence operated properly, with early MC6800 processors, only if the preceding instruction was odd (Least Significant Bit = 1). Similarly it was advisable

to precede any SEI instruction with an odd opcode — such as NOP. These precautions are not necessary for MC6800 processors indicating manufacture in November 1977 or later.

Systems which require an interrupt window to be opened under program control should use a CLI-NOP-SEI sequence rather than CLI-SEI.

FIGURE 25 - CONDITION CODE REGISTER BIT DEFINITION

- H = Half-carry; set whenever a carry from b₃ to b₄ of the result is generated by ADD, ABA, ADC, cleared if no b₃ to b₄ carry, not affected by other instructions.
- I = Interrupt Mask, set by hardware or software interrupt or SEI instruction, cleared by CLI instruction. (Normally not used in arithmetic operations) Restored to a zero as a result of an RT1 instruction if I_m stored on the stacked is low.
- N = Negative, set if high order bit (b7) of result is set, cleared otherwise.
- Z = Zero, set if result = 0, cleared otherwise.
- V = Overlow; set if there was arithmetic overflow as a result of the operation, cleared otherwise.
- C = Carry, set if there was a carry from the most significant bit (b₇) of the result; cleared otherwise.

TABLE 5 - CONDITION CODE REGISTER INSTRUCTIONS

| | | | | | | | CON | D CC | DE | REG | |
|----------------------|----------|----|-------|----|-------------------|---|-----|------|----|-----|---|
| | | IM | IPLIE | D | : | 5 | 4 | 3 | 2 | 1 | 0 |
| OPERATIONS | MNEMONIC | OP | ~ | ## | BOOLEAN OPERATION | H | 1 | N | z | ٧ | C |
| Clear Carry | CLC | 0C | 2 | 1 | 0 → C | • | ٠ | • | • | • | R |
| Clear Interrupt Mask | CLI | 0E | 2 | 1 | 0 → I | • | R | • | • | • | • |
| Clear Overflow | CLV | 0A | 2 | 1 | 0 → V | • | • | • | • | R | • |
| Set Carry | SEC | 0D | 2 | 1 | 1 → C | • | • | • | • | • | S |
| Set Interrupt Mask | SEI | 0F | 2 | 1 | 1 → I | • | S | • | • | • | • |
| Set Overflow | SEV | 0B | 2 | 1 | 1 → V | • | • | • | • | ls | • |
| Acmltr A → CCR | TAP | 06 | 2 | 1 | A → CCR | | | —(· | D- | | |
| CCR → AcmItr A | TPA | 07 | 2 | 1 | CCR → A | • | • | • | • | • | • |

- R = Reset
- S = Set
- = Not affected
- (ALL) Set according to the contents of Accumulator A

ADDRESSING MODES

The MPU operates on 8-bit binary numbers presented to it via the Data Bus. A given number (byte) may represent either data or an instruction to be executed, depending on where it is encountered in the control program. The M6800 has 72 unique instructions, however, it recognizes and takes action on 197 of the 256 possibilitis that can occur using an 8-bit word length. This larger number of instructions results from the fact that many of the executive instructions have more than one addressing mode.

These addressing modes refer to the manner in which the program causes the MPU to obtain its instructions and data. The programmer must have a method for addressing the MPU's internal registers and all of the external memory locations

Selection of the desired addressing mode is made by the user as the source statements are written. Translation into

appropriate opcode then depends on the method used. If manual translation is used, the addressing mode is inherent in the opcode. For example, the Immediate, Direct, Indexed, and Extended modes may all be used with the ADD instruction. The proper mode is determined by selecting (hexadecimal notation) 8B, 9B, AB, or BB, respectively

The source statement format includes adequate information for the selection if an assembler program is used to generate the opcode. For instance, the Immediate mode is selected by the Assembler whenever it encounters the "#" symbol in the operand field. Similarly, an "X" in the operand field causes the Indexed mode to be selected. Only the Relative mode applies to the branch instructions, therefore, the mnemonic instruction itself is enough for the Assembler to determine addressing mode.

For the instructions that use both Direct and Extended modes, the Assembler selects the Direct mode if the operand value is in the range 0-255 and Extended otherwise. There are a number of instructions for which the Extended mode is valid but the Direct is not For these instructions, the Assembler automatically selects the Extended mode even if the operand is in the 0-255 range. The addressing modes are summarized in Figure 26.

Inherent (Includes "Accumulator Addressing" Mode)

The successive fields in a statement are normally separated by one or more spaces. An exception to this rule occurs for instructions that use dual addressing in the operand field and for instructions that must distinguish between the two accumulators. In these cases, A and B are

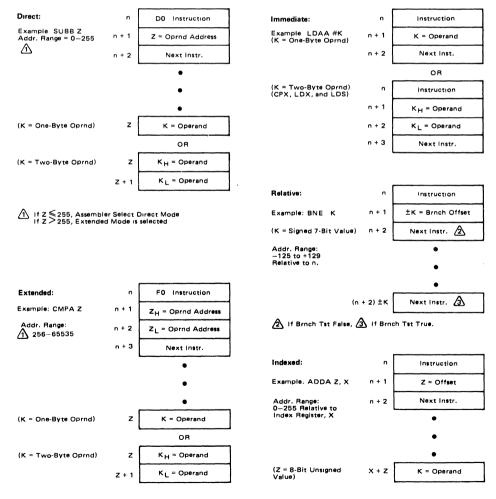
"operands" but the space between them and the operator may be omitted. This is commonly done, resulting in apparent four character mnemonics for those instructions

The addition instruction, ADD, provides an example of dual addressing in the operand field.

Operator Operand ADDA Comment ADD ADD CONTENTS OF MEM12 TO ACCA ADDB MEM12 ADD CONTENTS OF MEM12 TO ACCB

The example used earlier for the test instruction, TST, also applies to the accumulators and uses the "accumulator addressing mode" to designate which of the two accumulators is being tested.

FIGURE 26 - ADDRESSING MODE SUMMARY



. Operator Comment
TSTB TEST CONTENTS OF ACCB
or

TSTA TEST CONTENTS OF ACCA

A number of the instructions either alone or together with an accumulator operand contain all of the address information that is required, that is, "inherent" in the instruction itself. For instance, the instruction ABA causes the MPU to add the contents of accimulators A and B together and place the result in accumulator A. The instruction INCB, another example of "accumulator addressing," causes the contents of accumulator B to be increased by one. Similarly, INX, increment the Index Register, causes the contents of the Index Register to be increased by one.

Program flow for instructions of this type is illustrated in Figures 27 and 28. In these figures, the general case is shown on the left and a specific example is shown on the right. Numerical examples are in decimal notation. Instructions of this type require only one byte of opcode. Cycle-by-cycle operation of the inherent mode is shown in Table 6.

 $\label{lem:lemmod} \begin{tabular}{ll} \textbf{Immediate Addressing Mode} & - & \textbf{In the Immediate addressing mode, the operand is the value that is to be operated on.} \\ \end{tabular}$

| Operator | Operand | Comment |
|----------|---------|-------------------|
| LDAA | #25 | LOAD 25 INTO ACCA |

causes the MPU to "immediately load accumulator A with the value 25", no further address reference is required. The Immediate mode is selected by preceding the operand value with the "#" symbol Program flow for this addressing mode is illustrated in Figure 29

The operand format allows either properly defined symbols or numerical values. Except for the instructions CPX, LDX, and LDS, the operand may be any value in the range 0 to 255. Since Compare Index Register (LDX), Load Index Register (LDX), and Load Stack Pointer (LDS), require 16-bit values, the immediate mode for these three instructions require two-byte operands. In the Immediate addressing

mode, the "address" of the operand is effectively the memory location immediately following the instruction itself Table 7 shows the cycle-by-cycle operation for the immediate addressing mode

Direct and Extended Addressing Modes — In the Direct and Extended inodes of addressing, the operand field of the source statement is the *address* of the value that is to be operated on. The Direct and Extended modes differ only in the range of memory locations to which they can direct the MPU. Direct addressing generates a single 8-bit operand and, hence, can address only memory locations 0 through 255; a two byte operand is generated for Extended addressing, enabling the MPU to reach the remaining memory locations, 256 through 65535. An example of Direct addressing and its effect on program flow is illustrated in Figure 30

The MPU, after encountering the opcode for the instruction LDAA (Direct) at memory location 5004 (Program Counter = 5004), looks in the next location, 5005, for the address of the operand. It then sets the program counter equal to the value found there (100 in the example) and fetches the operand, in this case a value to be loaded into accumulator A, from that location. For instructions requiring a two-byte operand such as LDX (Load the Index Register), the operand bytes would be retrieved from locations 100 and 101 Table 8 shows the cycle-by-cycle operation for the direct mode of addressing.

Extended addressing, Figure 31, is similar except that a two-byte address is obtained from locations 5007 and 5008 after the LDAB (Extended) opcode shows up in location 5006 Extended addressing can be thought of as the "standard" addressing mode, that is, it is a method of reaching any place in memory. Direct addressing, since only one address byte is required, provides a faster method of processing data and generates fewer bytes of control code. In most applications, the direct addressing range, memory locations 0-255, are reserved for RAM. They are used for data buffering and temporary storage of system variables, the area in which faster addressing is of most value Cycle-by-cycle operation is shown in Table 9 for Extended Addressing.

FIGURE 27 - INHERENT ADDRESSING

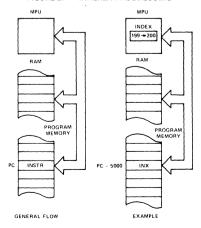
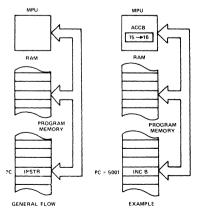


FIGURE 28 — ACCUMULATOR ADDRESSING



Relative Address Mode - In both the Direct and Extended modes, the address obtained by the MPU is an absolute numerical address. The Relative addressing mode, implemented for the MPU's branch instructions, specifies a memory location relative to the Program Counter's current location Branch instructions generate two bytes of machine code, one for the instruction opcode and one for the "relative" address (see Figure 32) Since it is desirable to be able to branch in either direction, the 8-bit address byte is interpreted as a signed 7-bit value, the 8th bit of the operand is treated as a sign bit, "0" = plus and "1" = minus The remaining seven bits represent the numerical value. This results in a relative addressing range of ± 127 with respect to the location of the branch instruction itself. However, the branch range is computed with respect to the next instruction that would be executed if the branch conditions are not satisfied Since two bytes are generated, the next instruction is located at PC+2 If D is defined as the address of the branch destination, the range is then

 $(PC + 2) - 127 \le D \le (PC + 2) + 127$

(

$PC - 125 \le D \le PC + 129$

that is, the destination of the branch instruction must be within $-125\ \text{to}\ +129\ \text{memory locations}$ of the branch instruction itself. For transferring control beyond this range,

the unconditional jump (JMP), jump to subroutine (JSR), and return from subroutine (RTS) are used.

In Figure 32, when the MPU encounters the opcode for BEQ (Branch if result of last instruction was zero), it tests the Zero bit in the Condition Code Register. If that bit is "0," indicating a non-zero result, the MPU continues execution with the next instruction (in location 5010 in Figure 32). If the previous result was zero, the branch condition is satisfied and the MPU adds the offset, 15 in this case, to PC+2 and branches to location 5025 for the next instruction.

The branch instructions allow the programmer to efficiently direct the MPU to one point or another in the control program depending on the outcome of test results. Since the control program is normally in read-only memory and cannot be changed, the relative address used in execution of branch instructions is a constant numerical value. Cycle-by-cycle operation is shown in Table 10 for relative addressing.

Indexed Addressing Mode — With Indexed addressing, the numerical address is variable and depends on the current contents of the Index Register A source statement such as

Operator Operand Comment
STAA X PUT A IN INDEXED LOCATION

causes the MPU to store the contents of accumulator A in

TABLE 6 - INHERENT MODE CYCLE-BY-CYCLE OPERATION

| Address Mode and Instructions | Cycles | Cycle # | VMA Line | Address Bus | R/W Line | Data Bus |
|---|----------|------------|-------------|----------------------------|-------------|--|
| ABA DAA SEC | T | 1 | 1 | Op Code Address | 1 1 | Op Code |
| ASL DEC SEI ASR INC SEV CBA LSR TAB CLC NEG TAP CLI NOP TBA CLR ROL TPA CLV ROR TST COM SBA | 2 | 2 | 1 | Op Code Address + 1 | 1 | Op Code of Next Instruction |
| DES | † | 1 | 1 | Op Code Address | 1 | Op Code |
| DEX | | 2 | 1 | Op Code Address + 1 | 1 | Op Code of Next Instruction |
| INS INX | 4 | 3 | 0 | Previous Register Contents | 1 | Irrelevant Data (Note 1) |
| | | 4 | 0 | New Register Contents | 1 | Irrelevant Data (Note 1) |
| PSH | 1 | 1 | 1 | Op Code Address | 1 | Op Code |
| | ١. | 2 | 1 | Op Code Address + 1 | 1 | Op Code of Next Instruction |
| | 4 | 3 | 1 | Stack Pointer | 0 | Accumulator Data |
| | | 4 | 0 | Stack Pointer - 1 | 1 | Accumulator Data |
| PUL | | 1 | 1 | Op Code Address | 1 | Op Code |
| | 4 | 2 | 1 | Op Code Address + 1 | 1 | Op Code of Next Instruction |
| | 4 | 3 | 0 | Stack Pointer | 1 | Irrelevant Data (Note 1) |
| | 1 | 4 | 1 | Stack Pointer + 1 | 1 | Operand Data from Stack |
| TSX | 1 | 1 | 1 | Op Code Address | 1 | Op Code |
| | 4 | 2 | 1 | Op Code Address + 1 | 1 | Op Code of Next Instruction |
| | 4 | 3 | 0 | Stack Pointer | 1 | Irrelevant Data (Note 1) |
| | 1 | 4 | 0 | New Index Register | 1 | Irrelevant Data (Note 1) |
| TXS | | 1 | 1 | Op Code Address | 1 | Op Code |
| | 4 | 2 | 1 | Op Code Address + 1 | 1 | Op Code of Next Instruction |
| | * | 3 | 0 | Index Register | 1 | Irrelevant Data |
| | | 4 | 0 | New Stack Pointer | 1 | Irrelevant Data |
| RTS | | 1 | 1 | Op Code Address | 1 | Op Code |
| | 1 | 2 | 1 | Op Code Address + 1 | 1 | Irrelevant Data (Note 2) |
| | 5 | 3 | 0 | Stack Pointer | 1 | Irrelevant Data (Note 1) |
| | | 4 | 1 | Stack Pointer + 1 | 1 | Address of Next Instruction (High Order Byte) |
| | | 5 | 1 | Stack Pointer + 2 | 1 | Address of Next Instruction (Low Order Byte) |

TABLE 6 - INHERENT MODE CYCLE-BY-CYCLE OPERATION (CONTINUED)

| Address Mode | | Cycle | | | R/W | |
|------------------|--------|-------|------|----------------------------|------|--|
| and Instructions | Cycles | # | Line | Address Bus | Line | Data Bus |
| WAI | Γ | 1 | 1 | Op Code Address | i | Op Code |
| WAI | | 2 | 1 | Op Code Address + 1 | 1 | Op Code of Next Instruction |
| | | 3 | 1 | Stack Pointer | 0 | Return Address (Low Order Byte) |
| | l | 4 | 1 | Stack Pointer — 1 | 0 | Return Address (High Order Byte) |
| | 9 | 5 | 1 | Stack Pointer — 2 | 0 | Index Register (Low Order Byte) |
| | | 6 | 1 | Stack Pointer — 3 | 0 | Index Register (High Order Byte) |
| | 1 | 7 | 1 | Stack Pointer — 4 | 0 | Contents of Accumulator A |
| | ł | 8 | 1 | Stack Pointer — 5 | 0 | Contents of Accumulator B |
| | ļ | 9 | 1 | Stack Pointer — 6 (Note 3) | 1 | Contents of Cond. Code Register |
| RTI | | 1 | 1 | Op Code Address | 1 | Op Code |
| | Ì | 2 | 1 | Op Code Address + 1 | 1 | Irrelevant Data (Note 2) |
| | 1 | 3 | 0 | Stack Pointer | 1 | Irrelevant Data (Note 1) |
| | | 4 | 1 | Stack Pointer + 1 | 1 | Contents of Cond Code Register from Stack |
| } | 10 | 5 | 1 | Stack Pointer + 2 | 1 | Contents of Accumulator B from Stack |
| | ĺ | 6 | 1 | Stack Po.nter + 3 | 1 | Contents of Accumulator A from Stack |
| | | 7 | 1 | Stack Pointer + 4 | 1 | Index Register from Stack (High Order Byte) |
| | | 8 | 1 | Stack Pointer + 5 | 1 | Index Register from Stack (Low Order Byte) |
| | | 9 | 1 | Stack Pointer + 6 | 1 | Next Instruction Address from Stack (High Order Byte) |
| | | 10 | 1 | Stack Pointer + 7 | 1 | Next Instruction Address from Stack (Low Order Byte) |
| SWI | | 1 | 1 | Op Code Address | 1 | Op Code |
| | | 2 | 1 | Op Code Address + 1 | 1 | Irrelevant Data (Note 1) |
| | l | 3 | 1 | Stack Pointer | 0 | Return Address (Low Order Byte) |
| | | 4 | 1 | Stack Pointer — 1 | 0 | Return Address (High Order Byte) |
| | | 5 | 1 | Stack Pointer - 2 | 0 | Index Register (Low Order Byte) |
| | 12 | 6 | 1 | Stack Pointer - 3 | 0 | Index Register (High Order Byte) |
| | | 7 | 1 | Stack Pointer — 4 | 0 | Contents of Accumulator A |
| | | 8 | 1 | Stack Pointer 5 | 0 | Contents of Accumulator B |
| | 1 | 9 | 1 | Stack Pointer - 6 | 0 | Contents of Cond Code Register |
| | 1 | 10 | 0 | Stack Pointer - 7 | 1 | Irrelevant Data (Note 1) |
| | | 11 | 1 | Vector Address FFFA (Hex) | 1 | Address of Subroutine (High Order Byte) |
| | | 12 | 1 | Vector Address FFFB (Hex) | 1 | Address of Subroutine (Low Order Byte) |

Note 1 If device which is addressed during this cycle uses VMA, then the Data Bus will go to the high impedance three-state condition.

Note 3. While the MPU is waiting for the interrupt, Bus Available will go high indicating the following states of the control lines. VMA is low; Address Bus, R/W, and Data Bus are all in the high impedance state

the memory location specified by the contents of the Index Register (recall that the label "X" is reserved to designate the Index Register) Since there are instructions for manipulating X during program execution (LDX, INX, DEC, etc.), the Indexed addressing mode provides a dynamic "on the fly" way to modify program activity

The operand field can also contain a numerical value that will be automatically added to X during execution. This format is illustrated in Figure 33.

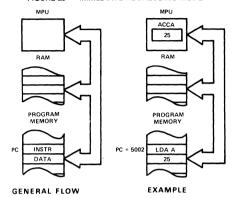
When the MPU encounters the LDAB (Indexed) opcode in

location 5006, it looks in the next memory location for the value to be added to X (5 in the example) and calculates the required address by adding 5 to the present Index Register value of 400. In the operand format, the offset may be represented by a label or a numerical value in the range 0-255 as in the example. In the earlier example, STAA X, the operand is equivalent to 0, X, that is, the 0 may be omitted when the desired address is equal to X. Table 11 shows the cycle-by-cycle operation for the Indexed Mode of Addressing

Depending on bus capacitance, data from the previous cycle may be retained on the Data Bus.

Note 2 Data is ignored by the MPU

FIGURE 29 - IMMEDIATE ADDRESSING MODE



MPU MPU ACCA 35

FIGURE 30 - DIRECT ADDRESSING MODE

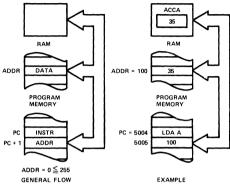


TABLE 7 - IMMEDIATE MODE CYCLE-BY-CYCLE OPERATION

| Address Mode and Instructions | Cycles | Cycle # | VMA Line | Address Bus | R/W Line | Data Bus |
|--|--------|------------|-------------|---------------------|-------------|--------------------------------|
| ADC EOR | T | 1 | 1 | Op Code Address | 1 | Op Code |
| ADD LDA AND ORA BIT SBC CMP SUB | 2 | 2 | 1 | Op Code Address + 1 | 1 | Operand Data |
| CPX | | 1 | 1 | Op Code Address | 1 | Op Code |
| LDS LDX | 3 | 2 | 1 | Op Code Address + 1 | 1 | Operand Data (High Order Byte) |
| | 1 | 3 | 1 1 | Op Code Address + 2 | 1 | Operand Data (Low Order Byte) |

TABLE 8 - DIRECT MODE CYCLE-BY-CYCLE OPERATION

| Address Mode and Instructions | Cycles | Cycle # | VMA Line | Address Bus | R/W Line | Data Bus |
|-------------------------------|--------|------------|-------------|------------------------|-------------|---------------------------------|
| | | | | | | |
| ADC EOR | | 1 | 1 | Op Code Address | 1 | Op Code |
| ADD LDA AND ORA | 3 | 2 | 1 | Op Code Address + 1 | 1 | Address of Operand |
| BIT SBC CMP SUB | - | 3 | 1 | Address of Operand | 1 | Operand Data |
| CPX | | 1 | 1 | Op Code Address | 1 | Op Code |
| LDS LDX | 4 | 2 | 1 | Op Code Address + 1 | 1 | Address of Operand |
| | - | 3 | 1 | Address of Operand | 1 | Operand Data (High Order Byte) |
| | | 4 | 1 | Operand Address + 1 | 1 | Operand Data (Low Order Byte) |
| STA | | 1 | 1 | Op Code Address | 1 | Op Code |
| | 4 | 2 | 1 | Op Code Address + 1 | 1 | Destination Address |
| | | 3 | 0 | Destination Address | 1 | Irrelevant Data (Note 1) |
| | | 4 | 1 | Destination Address | 0 | Data from Accumulator |
| STS | | 1 | 1 | Op Code Address | 1 | Op Code |
| STX | | 2 | 1 1 | Op Code Address + 1 | 1 | Address of Operand |
| | 5 | 3 | 0 | Address of Operand | 1 | Irrelevant Data (Note 1) |
| | | 4 | 1 | Address of Operand | 0 | Register Data (High Order Byte) |
| | | 5 | 1 | Address of Operand + 1 | 0 | Register Data (Low Order Byte) |

Note 1 If device which is address during this cycle uses VMA, then the Data Bus will go to the high impedance three-state condition Depending on bus capacitance, data from the previous cycle may be retained on the Data Bus

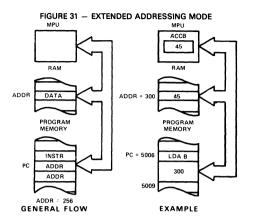


TABLE 9 - EXTENDED MODE CYCLE-BY-CYCLE

| Address Mode and Instructions | Cycles | Cycle | VMA Line | Address Bus | R/W Line | Data Bus |
|-------------------------------|--------|-------|--------------------|-----------------------------|-------------|---|
| STS | | 1 | 1 | Op Code Address | 1 | Op Code |
| STX | | 2 | 1 | Op Code Address + 1 | 1 | Address of Operand (High Order Byte) |
| | 6 | 3 | 1 | Op Code Address + 2 | 1 | Address of Operand (Low Order Byte) |
| | • | 4 | 0 | Address of Operand | 1 | Irrelevant Data (Note 1) |
| | 1 | 5 | 1 | Address of Operand | 0 | Operand Data (High Order Byte) |
| | } | 6 | 1 | Address of Operand + 1 | 0 | Operand Data (Low Order Byte) |
| JSR | | 1 | 1 | Op Code Address | 1 | Op Code |
| | | 2 | 1 | Op Code Address + 1 | 1 | Address of Subroutine (High Order Byte) |
| | | 3 | 1 | Op Code Address + 2 | 1 | Address of Subroutine (Low Order Byte) |
| | | 4 | 1 | Subroutine Starting Address | 1 | Op Code of Next Instruction |
| | 9 | 5 | 1 | Stack Pointer | 0 | Return Address (Low Order Byte) |
| | | 6 | 1 | Stack Pointer 1 | 0 | Return Address (High Order Byte) |
| | | 7 | 0 | Stack Pointer 2 | 1 | Irrelevant Data (Note 1) |
| | 1 | 8 | 0 | Op Code Address + 2 | 1 | Irrelevant Data (Note 1) |
| | 1 | 9 | 1 | Op Code Address + 2 | 1 | Address of Subroutine (Low Order Byte) |
| JMP | † | 1 | 1 | Op Code Address | 1 | Op Code |
| | 3 | 2 | 1 | Op Code Address + 1 | 1 | Jump Address (High Order Byte) |
| | | 3 | 1 | Op Code Address + 2 | 1 | Jump Address (Low Order Byte) |
| ADC EOR | | 1 | 1 | Op Code Address | 1 | Op Code |
| ADD LDA | | 2 | 1 | Op Code Address + 1 | 1 | Address of Operand (High Order Byte) |
| AND ORA BIT SBC | 4 | 3 | 1 | Op Code Address + 2 | 1 | Address of Operand (Low Order Byte) |
| CMP SUB | | 4 | 1 | Address of Operand | 1 | Operand Data |
| CPX | | 1 | 1 | Op Code Address | 1 | Op Code |
| LDS | i | 2 | 1 | Op Code Address + 1 | 1 | Address of Operand (High Order Byte) |
| LDX | 5 | 3 | 1 | Op Code Address + 2 | 1 | Address of Operand (Low Order Byte) |
| | 1 | 4 | 1 | Address of Operand | 1 | Operand Data (High Order Byte) |
| | | 5 | 1 | Address of Operand + 1 | 1 | Operand Data (Low Order Byte) |
| STA A | | 1 | 1 | Op Code Address | 1 | Op Code |
| STA B | | 2 | 1 | Op Code Address + 1 | 1 | Destination Address (High Order Byte) |
| | 5 | 3 | 1 | Op Code Address + 2 | 1 | Destination Address (Low Order Byte) |
| | 1 | 4 | 0 | Operand Destination Address | 1 | Irrelevant Data (Note 1) |
| | 1 | 5 | 1 | Operand Destination Address | 0 | Data from Accumulator |
| ASL LSR | | 1 | 1 | Op Code Address | 1 | Op Code |
| ASR NEG | | 2 | 1 | Op Code Address + 1 | 1 | Address of Operand (High Order Byte) |
| CLR ROL COM ROR | 6 | 3 | 1 | Op Code Address + 2 | 1 | Address of Operand (Low Order Byte) |
| DEC TST INC | " | 4 | 1 | Address of Operand | 1 | Current Operand Data |
| INC | | 5 | 0 | Address of Operand | 1 | Irrelevant Data (Note 1) |
| | | 6 | 1/0 (Note 2) | Address of Operand | 0 | New Operand Data (Note 2) |

Note 1 If device which is addressed during this cycle uses VMA, then the Data Bus will go to the high impedance three-state condition.

Depending on bus capacitance, data from the previous cycle may be retained on the Data Bus

Note 2 For TST, VMA = 0 and Operand data does not change

FIGURE 32 — RELATIVE ADDRESSING MODE

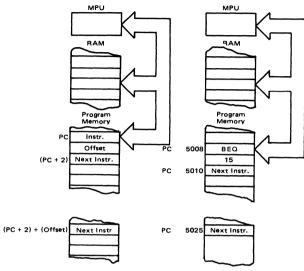


FIGURE 33 — INDEXED ADDRESSING MODE

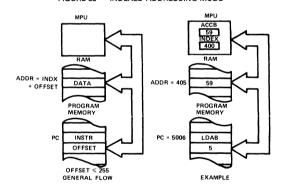


TABLE 10 - RELATIVE MODE CYCLE-BY-CYCLE OPERATION

| Address Mode and Instructions | | | VMA Line | Address Bus | R/W Line | Data Bus |
|---|---|-------------|-------------|--|-------------|---|
| BCC BHI BNE BCS BLE BPL | | 1 | 1 | Op Code Address | 1 | Op Code |
| BEQ BLS BRA BGE BLT BVC BGT BMI BVS | 4 | 2 3 4 | 0 | Op Code Address + 1 Op Code Address + 2 Branch Address | 1 1 | Branch Offset Irrelevant Data (Note 1) Irrelevant Data (Note 1) |
| BSR | | 1 2 | 1 | Op Code Address Op Code Address + 1 | 1 | Op Code Branch Offset |
| | | 3 4 | 0 | Return Address of Main Program Stack Pointer | 1 0 | Irrelevant Data (Note 1) Return Address (Low Order Byte) |
| | 8 | 5 | 1 0 | Stack Pointer — 1 Stack Pointer — 2 | 0 | Return Address (High Order Byte) |
| | | 7 8 | 0 | Return Address of Main Program Subroutine Address | 1 | Irrelevant Data (Note 1) Irrelevant Data (Note 1) |

Note 1. If device which is addressed during this cycle uses VMA, then the Data Bus will go to the high impedance three-state condition.

Depending on bus capacitance, data from the previous cycle may be retained on the Data Bus.

TABLE 11 - INDEXED MODE CYCLE-BY-CYCLE

| Address Mode and Instructions | Cycles | Cycle # | VMA Line | Address Bus | R/W Line | Data Bus |
|-------------------------------|--|------------|--------------|---|--|----------------------------------|
| INDEXED | | - | | | | |
| JMP | | 1 | 1 | Op Code Address | 1 | Op Code |
| | 4 | 2 | 1 | Op Code Address + 1 | 1 | Offset |
| | 1 7 | 3 | 0 | Index Register | 1 | Irrelevant Data (Note 1) |
| | | 4 | 0 | Index Register Plus Offset (w/o Carry) | 1 | Irrelevant Data (Note 1) |
| ADC EOR | | 1 | 1 | Op Code Address | 1 | Op Code |
| ADD LDA AND ORA | | 2 | 1 | Op Code Address + 1 | 1 | Offset |
| BIT SBC | 5 | 3 | 0 | Index Register | 1 | Irrelevant Data (Note 1) |
| CMP SUB | | 4 | 0 | Index Register Plus Offset (w/o Carry) | 1 | Irrelevant Data (Note 1) |
| | | 5 | 1 | Index Register Plus Offset | 1 | Operand Data |
| CPX | | 1 | 1 | Op Code Address | 1 | Op Code |
| LDS LDX | ŀ | 2 | 1 | Op Code Address + 1 | 1 | Offset |
| | 6 | 3 | 0 | Index Register | 1 | Irrelevant Data (Note 1) |
| | • | 4 | 0 | Index Register Plus Offset (w/o Carry) | 1 | Irrelevant Data (Note 1) |
| | i | 5 | 1 | Index Register Plus Offset | 1 | Operand Data (High Order Byte) |
| | | 6 | 1 | Index Register Plus Offset + 1 | 1 | Operand Data (Low Order Byte) |
| STA | | 1 | 1 | Op Code Address | 1 | Op Code |
| | 1 | 2 | 1 | Op Code Address + 1 | 1 | Offset |
| | 6 | 3 | 0 | Index Register | 1 | Irrelevant Data (Note 1) |
| | l | 4 | 0 | Index Register Plus Offset (w/o Carry) | 1 | Irrelevant Data (Note 1) |
| | | 5 | 0 | Index Register Plus Offset | 1 | Irrelevant Data (Note 1) |
| | | 6 | 1 | Index Register Plus Offset | 0 | Operand Data |
| ASL LSR ASR NEG | 1 | 1 | 1 | Op Code Address | 1 | Op Code |
| CLR ROL | 1 | 2 | 1 | Op Code Address + 1 | 1 | Offset |
| COM ROR DEC TST | 7 | 3 | 0 | Index Register | 1 | Irrelevant Data (Note 1) |
| INC | | 4 | 0 | Index Register Plus Offset (w/o Carry) | 1 | Irrelevant Data (Note 1) |
| | i | 5 | 1 | Index Register Plus Offset | 1 | Current Operand Data |
| | | 6 | 0 | Index Register Plus Offset | 1 | Irrelevant Data (Note 1) |
| | | 7 | 1/0 (Note | Index Register Plus Offset | 0 | New Operand Data (Note 2) |
| STS | ļ | 1 | 2) | Op Code Address | | Op Code |
| STX | | 2 | 1 | Op Code Address + 1 | 1 | Offset |
| | l | 3 | 0 | Index Register | ; | Irrelevant Data (Note 1) |
| | 7 | 4 | 0 | Index Register Index Register Plus Offset (w/o Carry) | 1 | Irrelevant Data (Note 1) |
| | | 5 | 0 | Index Register Plus Offset | ; | Irrelevant Data (Note 1) |
| | 1 | 6 | 1 | Index Register Plus Offset | 0 | Operand Data (High Order Byte) |
| | 1 | 7 | | Index Register Plus Offset + 1 | 0 | Operand Data (Low Order Byte) |
| JSR | | 1 | 1 | Op Code Address | 1 | Op Code |
| | | 2 | 1 | Op Code Address + 1 | 1 | Offset |
| | | 3 | 0 | Index Register | 1 | Irrelevant Data (Note 1) |
| | 8 | 4 | 1 | Stack Pointer | 0 | Return Address (Low Order Byte) |
| | | 5 | 1 | Stack Pointer — 1 | 0 | Return Address (High Order Byte) |
| | | 6 | 0 | Stack Pointer – 2 | 1 | Irrelevant Data (Note 1) |
| | 1 | 7 | 0 | Index Register | 1 | Irrelevant Data (Note 1) |
| | | 8 | 0 | Index Register Plus Offset (w/o Carry) | 1 | Irrelevant Data (Note 1) |

Note 1. If device which is addressed during this cycle uses VMA, then the Data Bus will go to the high impedance three-state condition.

Depending on bus capacitance, data from the previous cycle may be retained on the Data Bus.

Note 2 For TST, VMA = 0 and Operand data does not change.



MICROCOMPUTER/MICROPROCESSOR (MCU/MPU)

The MC6801 is an 8-bit single-chip microcomputer unit (MCU) which significantly enhances the capabilities of the M6800 family of parts. It includes an upgraded M6800 microprocessor unit (MPU) with upwardsource and object-code compatibility. Execution times of key instructions have been improved and several new instructions have been added including an unsigned multiply. The MCU can function as a monolithic microcomputer or can be expanded to a 64K byte address space It is TTL compatible and requires one +5-volt power supply. Onchip resources include 2048 bytes of ROM, 128 bytes of RAM, a Serial Communications Interface (SCI), parallel I/O, and a three function Programmable Timer The MC6803 can be considered as an MC6801 operating in Modes 2 or 3. The MC6803NR is comparable to MC6801 operating in Mode 3. An EPROM version of the MC6801, the MC68701 microcomputer, is available for systems development. The MC68701 is pin and code compatible with the MC6801/03/03NR and can be used to emulate the MC6801/03/03NR. The MC68701 is described in a separate Advance Information publication MC6801 MCU Family features in-

- Enhanced MC6800 Instruction Set
- 8×8 Multiply Instruction
- Serial Communications Interface (SCI)
- Upward Source and Object Code Compatibility with the M6800
- 16-Bit Three-Function Programmable Timer
- Single-Chip or Expanded Operation to 64K Byte Address Space
- Bus Compatibility with the M6800 Family
- 2048 Bytes of ROM (MC6801)
- 128 Bytes of RAM (MC6801 and MC6803)
- 64 Bytes of RAM Retainable During Powerdown (MC6801 and MC6803)
- 29 Parallel I/O and Two Handshake Control Lines
- Internal Clock Generator with Divide-by-Four Output

PART NUMBER DESIGNATED BY SPEED

| MC6801 | MC68A01 |
|------------|-----------|
| MC6803 | MC68A03 |
| MC6803NR | MC68A03NR |
| (1.0 MHz) | (1.5 MHz) |
| MC6801-1 | MC68B01 |
| MC6803-1 | MC68B03 |
| MC6803NR-1 | MC68B03NR |

(2.0 MHz)

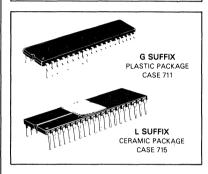
(1.25 MHz)

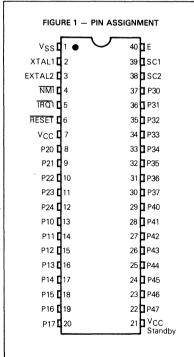
MC6801 MC6803 MC6803NR

MOS

(N-CHANNEL, SILICON-GATE, DEPLETION LOAD)

MICROCOMPUTER MICROPROCESSOR





MC6801 • MC6803 • MC6803NR

MAXIMUM RATINGS

| Rating | Symbol | Value | Unit |
|-----------------------------|------------------|-------------|------|
| Supply Voltage | Vcc | -03 to +70 | ٧ |
| Input Voltage | V _{in} | -03 to +70 | ٧ |
| Operating Temperature Range | *TA | 0 to 70 | °C |
| Storage Temperature Range | T _{stg} | -55 to +150 | °C |

^{*}An extended temperature device, the MC6801C is available with $T_A = -40$ °C to 85 °C

THERMAL CHARACTERISTICS

| Characteristic | Symbol | Value | Rating |
|--------------------|----------------------|-------|--------|
| Thermal Resistance | | | |
| Plastic | θ_{JA} | 50 | °C/W |
| Ceramic | | 50 | |

This device contains circuitry to protect the inputs against damage due to high static voltages or electric fields, however, it is advised that normal precautions be taken to avoid application of any voltage higher than maximum rated voltages to this high-impedance circuit. For proper operation it is recommended that V_{In} and V_{out} be constrained to the range VSS ≤ (Vin or Vout) ≤ VCC Input protection is enhanced by connecting unused inputs to either VDD or VSS

(2)

POWER CONSIDERATIONS

The average chip-junction temperature, T.J., in °C can be obtained from

$$T_{J} = T_{A} + (P_{D} \bullet \theta_{JA}) \tag{1}$$

Where.

T_A ≡ Ambient Temperature, °C

θJA≡Package Thermal Resistance, Junction-to-Ambient, °C/W

PD = PINT + PPORT

PINT = ICC × VCC, Watts - Chip Internal Power

PPORT = Port Power Dissipation, Watts - User Determined

For most applications PPORT ≪PINT and can be neglected PPORT may become significant if the device is configured to drive Darlington bases or sink LED loads

An approximate relationship between PD and TJ (if PPORT is neglected) is

$$P_D = K - (T_J + 273 ^{\circ}C)$$
Solving equations 1 and 2 for K gives. (2)

 $K = PD \bullet (TA + 273 \circ C) + \theta JA \bullet PD^2$

Where K is a constant pertaining to the particular part. K can be determined from equation 3 by measuring PD (at equilibrium) for a known TA. Using this value of K the values of PD and TJ can be obtained by solving equations (1) and (2) iteratively for any value of TA

CONTROL TIMING ($V_{CC} = 5.0 \text{ V } \pm 5\%$, $V_{SS} = 0$, $T_A = 0$ to 70°C)

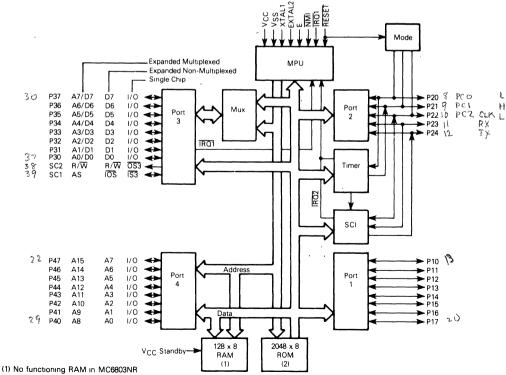
| 0 | Symbol | MC6801 | | MC6801-1 | | MC68A01 | | 1 MC68B01 | | Unit |
|----------------------------------|-----------------|--------|-----|----------|------|---------|-----|-----------|-----|------|
| Characteristic | | Min | Max | Min | Max | Min | Max | Min | Max | Unit |
| Frequency of Operation | fo | 05 | 10 | 05 | 1.25 | 05 | 15 | 05 | 20 | MHz |
| Crystal Frequency | fXTAL | 3 579 | 40 | 3 579 | 50 | 3 579 | 60 | 3 579 | 80 | MHz |
| External Oscillator Frequency | 4f _o | 20 | 40 | 20 | 50 | 20 | 60 | 20 | 80 | MHz |
| Crystal Oscillator Start Up Time | t _{rc} | - | 100 | - | 100 | | 100 | _ | 100 | ms |
| Processor Control Setup Time | tPCS | 200 | - | 170 | - | 140 | - | 110 | - | ns |

DC ELECTRICAL CHARACTERISTICS (V_{CC}=5.0 Vdc ±5% V_{SS}=0, T_A=0 to 70°C unless otherwise noted)

| Characteristic | Symbol | Min | Тур | Max | Unit | |
|---|--|-------------------------------------|---|-------------|------------------------------------|----|
| Input High Voltage | RESET Other Inputs* | V _{IH} | V _{SS} +40 V _{SS} +20 | _ | V _{CC} V _{CC} | ٧ |
| Input Low Voltage | All Inputs* | VIL | V _{SS} -03 | - | Vss+08 | ٧ |
| Input Load Current (V _{In} =0 to 2.4 V) | Port 4 SC1 | l _{in} | | - | 05 08 | mA |
| Input Leakage Current (V _{IN} = 0 to 5 25 V) | NMI, IRQ1, RESET | l _{in} | _ | 15 | 2 5 | μΑ |
| Three-State (Off State) Input Current (V _{IN} = 0 5 to 2.4 V) | P10-P17, P30-P37 P20-P24 | ^I TSI | - | 2 0 10 0 | 10 100 | μΑ |
| Output High Voltage (I _{lOad} = -100 μA, V _{CC} = min) (I _{lOad} = -65 μA, V _{CC} = min)** (I _{lOad} = -100 μA, V _{CC} = min) | P30-P37 P40-P47, E, SC1, SC2 Other Outputs | V _{ОН} | V _{SS} +24 V _{SS} +24 V _{SS} +24 | | - - - | ٧ |
| Output Low Voltage (I _{load} = 2 0 mA, V _{CC} = min) | All Outputs | VOL | - | - | V _{SS} +05 | ٧ |
| Darlington Drive Current (V _O = 1.5 V) | P10-P17 | ЮН | 10 | 25 | 10 0 | mA |
| Internal Power Dissipation (Measured at TA = 0° | C in Steady-State Operation) | PINT | _ | _ | 1200 | mW |
| Input Capacitance $(V_{IR} = 0, T_A = 25$ °C, $f_0 = 1.0$ MHz) | P30-P37, P40-P47, SC1 Other Inputs | C _{in} | <u> </u> | | 12 5 10 0 | pF |
| V _{CC} Standby | Powerdown Powerup | V _{SBB} V _{SB} | 4 0 4 75 | = | 5 25 5.25 | ٧ |
| Standby Current | Powerdown | ISBB | _ | _ | 60 | mA |

^{*}Except Mode Programming Levels, See Figure 16

FIGURE 2 - M6801 MICROCOMPUTER FAMILY BLOCK DIAGRAM



⁽²⁾ No functioning ROM in MC6803 and MC6803NR

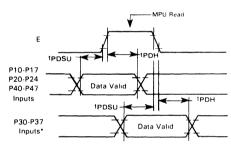
^{**}Negotiable to $-100\,\mu\text{A}$ (for further information contact the factory)

MC6801 • MC6803 • MC6803NR

PERIPHERAL PORT TIMING (Refer to Figures 3-6)

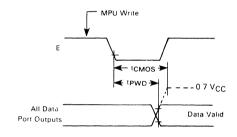
| Characteristics | Symbol | Min | Тур | Max | Unit |
|---|-------------------|-----|-----|------------|------|
| Peripheral Data Setup Time | ^t PDSU | 200 | | - | ns |
| Peripheral Data Hold Time | ^t PDH | 200 | - | _ | ns |
| Delay Time, Enable Positive Transition to OS3 Negative Transition | tosp1 | _ | - | 350 | ns |
| Delay Time, Enable Positive Transition to OS3 Positive Transition | tOSD2 | _ | - | 350 | ns |
| Delay Time, Enable Negative Transition to Peripheral Data Valid Port 1 Port 2, 3, 4 | tPWD | | - | 350 350 | ns |
| Delay Time, Enable Negative Transition to Peripheral CMOS Data Valid | tCMOS | - | - | 20 | μS |
| Input Strobe Pulse Width | †PWIS | 200 | - | - | ns |
| Input Data Hold Time | tıн | 50 | _ | - | ns |
| Input Data Setup Time | tis | 20 | _ | _ | ns |

FIGURE 3 — DATA SETUP AND HOLD TIMES (MPU READ)



*Port 3 Non-Latched Operation (LATCH ENABLE 0)

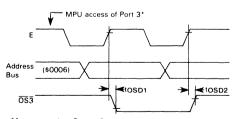
FIGURE 4 — DATA SETUP AND HOLD TIMES (MPU WRITE)



NOTES

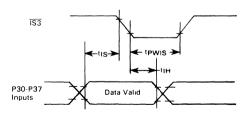
- 1 10 k Pullup resistor required for Port 2 to reach 0.7 VCC
- 2 Not applicable to P21
- 3 Port 4 cannot be pulled above VCC

FIGURE 5 — PORT 3 OUTPUT STROBE TIMING (MC6801 SINGLE-CHIP MODE)



*Access matches Output Strobe Select (OSS = 0, a read, OSS = 1, a write)

FIGURE 6 — PORT 3 LATCH TIMING (MC6801 SINGLE-CHIP MODE)



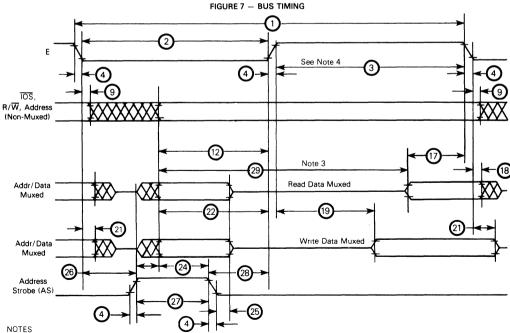
NOTE Timing measurements are referenced to and from a low voltage of 0.8 volts and a high voltage of 2.0 volts, unless otherwise noted

BUS TIMING (See Notes 1 and 2)

| ldent. Number | Characteristics | Symbol | MC6801 MC6803 MC6803NR | | MC6801-1 MC6803-1 MC6803NR-1 | | MC68A01 MC68A03 MC68A03NR | | MC68B01 MC68B03 R MC68B03NR | | Unit |
|------------------|--------------------------------------|---------------------------------|------------------------------|------|------------------------------------|------|---------------------------------|------|-----------------------------------|----------|------|
| | | | Min | Max | Min. | Max | Min | Max | Min | Max | |
| 1 | Cycle Time | tcyc | 10 | 20 | 08 | 20 | 0 667 | 20 | 05 | 20 | μS |
| 2 | Pulse Width, E Low | PWEL | 430 | 1000 | 360 | 1000 | 300 | 1000 | 210 | 1000 | ns |
| 3 | Pulse Width, E High | PWEH | 450 | 1000 | 360 | 1000 | 300 | 1000 | 220 | 1000 | ns |
| 4 | Clock Rise and Fall Time | t _r , t _f | _ | 25 | - | 25 | _ | 25 | _ | 20 | ns |
| 9 | Address Hold Time | tAH | 20 | _ | 20 | - | 20 | - | 10 | _ | ns |
| 12 | Non-Muxed Address Valid Time to E* | tAV | 200 | _ | 150 | _ | 115 | - | 70 | - | ns |
| 17 | Read Data Setup Time | tDSR | 80 | _ | 70 | _ | 60 | _ | 40 | _ | ns |
| 18 | Read Data Hold Time | ^t DHR | 10 | _ | 10 | _ | 10 | _ | 10 | _ | ns |
| 19 | Write Data Delay Time | tDDW | _ | 225 | - | 200 | _ | 170 | _ | 120 | ns |
| 21 | Write Data Hold Time | tDHW | 20 | _ | 20 | _ | 20 | - | 10 | _ | ns |
| 22 | Muxed Address Valid Time to E Rise* | tAVM | 200 | _ | 150 | _ | 115 | _ | 80 | | ns |
| 24 | Muxed Address Valid Time to AS Fall* | tASL | 60 | _ | 50 | - | 40 | - | 20 | _ | ns |
| 25 | Muxed Address Hold Time | tAHL | 20 | _ | 20 | - | 20 | - | 10 | _ | ns |
| 26 | Delay Time, E to AS Rise* | tASD | 90** | _ | 70** | _ | 60** | _ | 45** | <u> </u> | ns |
| 27 | Pulse Width, AS High* | PWASH | 220 | _ | 170 | - | 140 | - | 110 | _ | ns |
| 28 | Delay Time, AS to E Rise* | tASED | 90 | _ | 70 | _ | 60 | _ | 45 | - | ns |
| 29 | Usable Access Time* (See Note 9) | tACC | 595 | _ | 465 | _ | 380 | _ | 270 | _ | ns |

^{*}At specified cycle time

**tASD parameters listed assume external TTL clock drive with 50% ±5% duty cycle. Devices driven by an external TTL clock with 50% ±1%. duty cycle or which use a crystal have the following tASD specifications 100 ms min (1.0 MHz devices), 80 ms min. (1.25 MHz device), 65 ms min. (1 5 MHz devices), 50 ms min. (2 0 MHz devices)



- 1 Voltage levels shown are $V_L \le 0.5$ V, $V_H \ge 2.4$ V, unless otherwise specified
- 2 Measurement points shown are 0 8 V and 2 0 V, unless otherwise specified
- 3 Usable access time is computed by 12+3-17+4
- 4 Memory devices should be enabled only during E high to avoid Port 3 bus contention

FIGURE 8 - CMOS LOAD

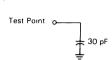
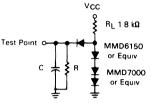


FIGURE 9 - TIMING TEST LOAD PORTS 1, 2, 3, 4



C = 90 pF for P30-P37, P40-P47, E, SC1, SC2 = 30 pF for P10-P17, P20-P24 R = 37 $\kappa\Omega$ for P40-P47, E, SC1, SC2 = 24 $\kappa\Omega$ for P10-P17, P20-P24 = 24 $\kappa\Omega$ for P30-P37

INTRODUCTION

The MC6801 is an 8-bit monolithic microcomputer which can be configured to function in a wide variety of applications. The facility which provides this extraordinary flexibility is its ability to be hardware programmed into eight different operating modes. The operating mode controls the configuration of 18 of the 40 MCU pins, available on-chip resources, memory map, location (internal or external) of interrupt vectors, and type of external bus. The configuration of the remaining 22 pins is not dependent on the operating mode.

Twenty-nine pins are organized as three 8-bit ports and one 5-bit port. Each port consists of at least a Data Register and a write-only Data Direction Register. The Data Direction Register is used to define whether corresponding bits in the Data Register are configured as an input (clear) or output (cest).

The term "port," by itself, refers to all of the hardware associated with the port. When the port is used as a "data port" or "I/O port," it is controlled by the port Data Direction Register and the programmer has direct access to the port pins using the port Data Register. Port pins are labled as Pij where i identifies one of four ports and j indicates the particular bit

The Microprocessor Unit (MPU) is an enhanced MC6800 MPU with additional capabilities and greater throughput. It is upward source and object code compatible with the MC6800 The programming model is depicted in Figure 10, where Accumulator D is a concatenation of Accumulators A and B A list of new operations added to the M6800 instruction set are shown in Table 1.

The MC6803 can be considered an MC6801 that operates in Modes 2 and 3 only. The MC6803NR is comparable to an MC6801 that operates in Mode 3 only.

FIGURE 10 - PROGRAMMING MODEL 8-Bit Accumulators A and B Or 16-Bit Double Accumulator D D 15 Х Index Register (X) 15 SP Stack Pointer (SP) PC Program Counter (PC) Condition Code Register (CCR) Carry/Borrow from MSB Overflow Zero Negative Interrupt Half Carry (From Bit 3)

OPERATING MODES

The MC6801 provides eight different operating modes (Modes 0 through 7), the MC6803 provides two operating modes (Modes 2 and 3), and the MC6803NR provides one operating mode (Mode 3). The operating modes are hardware selectable and determine the device memory map, the configuration of Port 3, Port 4, SC1, SC2, and the physical location of the interrupt vectors.

FUNDAMENTAL MODES

The eight operating modes can be grouped into three fundamental modes which refer to the type of bus it supports Single Chip, Expanded Non-Multiplexed, and Expanded Multiplexed Single chip modes include 4 and 7, Expanded

Non-Multiplexed is Mode 5 and the remaining five are Expanded Multiplexed modes Table 2 summarizes the characteristics of the operating modes

MC6801 Single-Chip Modes (4, 7)

In the Single-Chip Mode, the four MCU ports are configured as parallel input/output data ports, as shown in Figure 11. The MCU functions as a monolithic microcomputer in these two modes without external address or data buses. A maximum of 29 I/O lines and two Port 3 control lines are provided. Peripherals or another MCU can be interfaced to Port 3 in a loosely coupled dual processor configuration, as shown in Figure 12.

TABLE 1 — NEW INSTRUCTIONS

| Instruction | Description |
|--------------|---|
| ABX | Unsigned addition of Accumulator B to Index Register |
| ADDD | Adds (without carry) the double accumulator to memory and leaves the sum in the double accumulator |
| ASLD or LSLD | Shifts the double accumulator left (towards MSB) one bit, the LSB is cleared and the MSB is shifted into the C-bit |
| BHS | Branch if Higher or Same, unsigned conditional branch (same as BCC) |
| BLO | Branch if Lower, Unsigned conditional branch (same as BCS) |
| BRN | Branch Never |
| JSR | Additional addressing mode direct |
| LDD | Loads double accumulator from memory |
| LSL | Shifts memory or accumulator left (towards MSB) one bit, the LSB is cleared and the MSB is shifted into the C-bit (same as ASL) |
| LSRD | Shifts the double accumulator right (towards LSB) one bit, the MSB is cleared and the LSB is shifted into the C-bit |
| MUL | Unsigned multiply, multiplies the two accumulators and leaves the product in the double accumulator |
| PSHX | Pushes the Index Register to stack |
| PULX | Pulls the Index Register from stack |
| STD | Stores the double accumulator to memory |
| SUBD | Subtracts memory from the double accumulator and leaves the difference in the double accumulator |
| CPX | Internal processing modified to permit its use with any conditional branch instruction |

MC6801 • MC6803 • MC6803NR

In Single-Chip Test Mode (4), the RAM responds to \$XX80 through \$XXFF and the ROM is removed from the internal address map. A test program must first be loaded into the RAM using modes 0, 1, 2, or 6. If the MCU is Reset and then programmed into Mode 4, execution will begin at \$XXFE XXFF Mode 5 can be irreversibly entered from Mode 4 without asserting RESET by setting bit 5 of the Port 2 Data Register. This mode is used primarily to test Ports 3 and 4 in the Single-Chip and Non-Multiplexed Modes

MC6801 Expanded Non-Multiplexed Mode (5)

A modest amount of external memory space is provided in the Expanded Non-Multiplexed Mode while significant onchip resources are retained. Port 3 functions as an 8-bit bidirectional data bus and Port 4 is configured initially as an input data port. Any combination of the eight least-significant address lines may be obtained by writing to the Port 4 Data Direction Register Stated alternatively, any combination of A0 to A7 may be provided while retaining the remainder as input data lines. Internal pullup resistors pull the Port 4 lines high until the port is configured.

Figure 13 illustrates a typical system configuration in the Expanded Non-Multiplexed Mode. The MCU interfaces directly with M6800 family parts and can access 256 bytes of external address space at \$100 through \$1FF IOS provides an address decode of external memory (\$100-\$1FF) and can be used as a memory page select or chip select line

TABLE 2 - SUMMARY OF MC6801/03/03NR OPERATING MODES

| Common to all Modes: |
|--|
| Reserved Register Area |
| Port 1 |
| Port 2 |
| Programmable Timer |
| Serial Communications Interface |
| Single Chip Mode 7 |
| 128 bytes of RAM, 2048 bytes of ROM |
| Port 3 is a parallel I/O port with two control lines |
| Port 4 is a parallel I/O port |
| SC1 is Input Strobe 3 (IS3) |
| SC2 is Output Strobe 3 (OS3) |
| Expanded Non-Multiplexed Mode 5 |
| 128 bytes of RAM, 2048 bytes of ROM . |
| 256 bytes of external memory space |
| Port 3 is an 8-bit data bus |
| Port 4 is an input port/address bus |
| SC1 is Input/Output Select (IOS) |
| SC2 is Read/Write (R/W) |
| Expanded Multiplexed Modes 1, 2, 3, 6* |
| Four memory space options (64K address space) |
| (1) No internal RAM or ROM (Mode 3) |
| (2) Internal RAM, no ROM (Mode 2) |
| (3) Internal RAM and ROM (Mode 1) |
| (4) Internal RAM, ROM with partial address bus (Mode 6) |
| Port 3 is a multiplexed address/data bus |
| Port 4 is an address bus (inputs/address in Mode 6) |
| SC1 is Address Strobe (AS) |
| SC2 is Read/Write (R/W) |
| Test Modes 0 and 4 |
| Expanded Multiplexed Test Mode 0 |
| May be used to test RAM and ROM |
| Single Chip and Non-Multiplexed Test Mode 4 |
| (1) May be changed to Mode 5 without going through Reset |
| (2) May be used to test Ports 3 and 4 as I/O ports |

^{*}The MC6803 operates only in modes 2 and 3, the MC6803NR operates only in Mode 3

FIGURE 11 - SINGLE-CHIP MODE

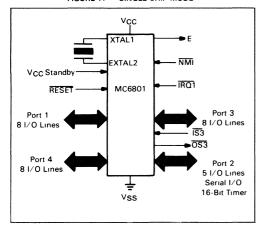


FIGURE 12 - SINGLE-CHIP DUAL PROCESSOR CONFIGURATION

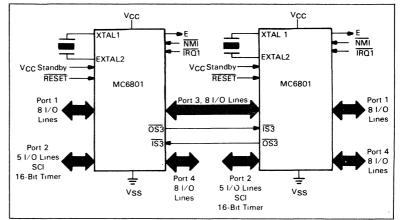
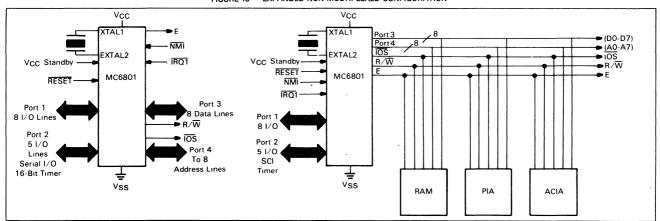


FIGURE 13 — EXPANDED NON-MULTIPLEXED CONFIGURATION



MC6801 • MC6803 • MC6803NR

Expanded-Multiplexed Modes (0, 1, 2, 3, 6)

A 64K byte memory space is provided in the expanded multiplexed modes. In each of the expanded multiplexed modes Port 3 functions as a time multiplexed address/data bus with address valid on the negative edge of Address Strobe (AS), and data valid while E is high. In Modes 0 to 3, Port 4 provides address lines A8 to A15. In Mode 6, however, Port 4 initially is configured at RESET as an input data port. The port 4 Data Direction Register can then be changed to provide any combination of address lines, A8 to A15. Stated alternatively, any subset of A8 to A15 can be provided while retaining the remaining port 4 lines as input data lines. Internal pullup resistors pull the Port 4 lines high until software configures the port.

In Mode 0, the Reset vector is external for the first two E-cycles after the positive edge of RESET, and internal thereafter. In addition, the internal and external data buses are connected so there must be no memory map overlap in order to avoid potential bus conflicts. Mode 0 is used primarily to verify the ROM pattern and monitor the internal data bus with the automated test equipment.

Only the MC6801 can operate in each of the expanded multplexed modes. The MC6803 operates only in Modes 2 and 3, while the MC6803NR operates only in Mode 3.

Figure 14 depicts a typical configuration for the Expanded-

Multiplexed Modes Address Strobe can be used to control a transparent D-type latch to capture addresses AO-A7, as shown in Figure 15 This allows Port 3 to function as a Data Bus when E is high

PROGRAMMING THE MODE

The operating mode is determined at RESET by the levels asserted on P22, P21, and P20. These levels are latched into PC2, PC1, and PC0 of the program control register on the positive edge of RESET. The operating mode may be read from the Port 2 Data Register as shown below, and programming levels and timing must be met as shown in Figure 16. A brief outline of the operating modes is shown in Table 3.

| PORT 2 DATA REGISTER | | | | | | | | | | | | |
|----------------------|-----|-----|-----|-----|-----|-----|-----|--------|--|--|--|--|
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | | | | | |
| PC2 | PC1 | PC0 | P24 | P23 | P22 | P21 | P20 | \$0003 | | | | |

Circuitry to provide the programming levels is dependent primarily on the normal system usage of the three pins. If configured as outputs, the circuit shown in Figure 17 may be used, otherwise, three-state buffers can be used to provide isolation while programming the mode.

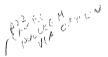


TABLE 3 - MODE SELECTION SUMMARY

| | Mode* | P22 PC2 | P21 PC1 | P20 PC0 | ROM | RAM | Interrupt Vectors | Bus Mode | Operating Mode |
|-----|-------|------------|------------|------------|------|------|----------------------|------------------------|--------------------------------|
| | 7 | Н | н | н | - 1 | 1 | 1 | 1 | Single Chip |
| , [| 6 | Н | н | L | ı | ı | ı | MUX ^(5, 6) | Multiplexed/Partial Decode |
| Ί | 5 | н | L | н | ı | ı | 1 | NMUX ^(5, 6) | Non-Multiplexed/Partial Decode |
| ſ | 4 | н | L | L | 1(2) | J(1) | I | 1 | Single Chip Test |
| T | 3 | L | н | Н | E | Е | E | MUX ⁽⁴⁾ | Multiplexed/No RAM or ROM |
| -[| 2 | (L) | (H) | (1) | E | 1 | E | MUX ⁽⁴⁾ | Multiplexed/RAM |
| I | 1 | L | L | н | ı | _ | E | MUX ⁽⁴⁾ | Multiplexed/RAM & ROM |
| Ī | 0 | L | L | L | ı | 1 | J(3) | MUX ⁽⁴⁾ | Multiplexed Test |

Legend

I — Internal

E — External

MUX — Multiplexed

NMUX — Non-Multiplexed

L — Logic "0"

H — Logic "1"

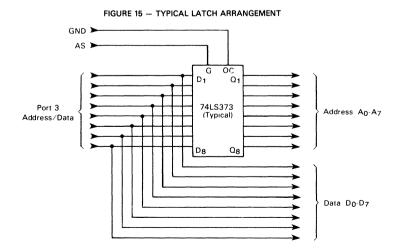
Notes

- (1) Internal RAM is addressed at \$XX80
 - (2) Internal ROM is disabled
 - (3) RESET vector is external for 2 cycles after RESET goes high
- (4) Addresses associated with Ports 3 and 4 are considered external in Modes 0, 1, 2, and 3
- (5) Addresses associated with Port 3 are considered external in Modes 5 and 6
- (6) Port 4 default is user data input, address output is optional by writing to Port 4 Data Direction Register

^{*}The MC6803 operates only in Modes 2 and 3, the MC6803NR operates only in Mode 3

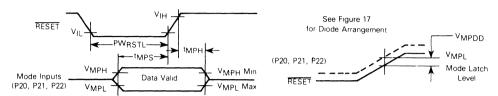
FIGURE 14 - EXPANDED MULTIPLEXED CONFIGURATION XTAL1 · NMI EXTAL2 Vcc Standby RESET MC6801 IRQ1 MC6803 MC6803NR Port 3 8 Lines Multiplexed Data Address 8 I/O Lines Port 2 Port 4 5 I/O Lines 8 Lines Address Bus Serial I/O 16-Bit Timer Vss Vçc XTAL1 Port 3 Data Bus (DO D7) EXTAL2 AS Latch VCC Standby Port 4 MC6801 Address Bus RESET (A0 A15) NMI MC6803 R/W IRQ1 MC6803NR ➤ R W Port 1 81/0 Port 2 51/0 SCI Timer vss RAM

NOTE To avoid data bus (Port 3) contention in the expanded multiplexed modes, memory devices should be enabled only during E high time



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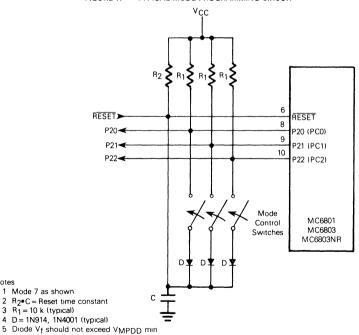
FIGURE 16 - MODE PROGRAMMING TIMING



MODE PROGRAMMING (Refer to Figure 16)

| Characteristic | Symbol | Min | Max | Unit |
|--|--------|-----|-----|----------|
| Mode Programming Input Voltage Low | VMPL | _ | 18 | V |
| Mode Programming Input Voltage High | VMPH | 40 | - | V |
| Mode Programming Diode Differential (If Diodes are Used) | VMPDD | 06 | _ | V |
| RESET Low Pulse Width | PWRSTL | 30 | - | E-Cycles |
| Mode Programming Setup Time | tMPS | 20 | - | E-Cycles |
| Mode Programming Hold Time | | | | |
| RESET Rise Time≥ 1 μs | tMPH | 0 | - | ns |
| RESET Rise Time<1 µs | | 100 | | |

FIGURE 17 - TYPICAL MODE PROGRAMMING CIRCUIT



MEMORY MAPS

Notes

The M6801 Family can provide up to 64K byte address space depending on the operating mode. A memory map for each operating mode is shown in Figure 18. In Modes 1R and

1 Mode 7 as shown

 $3 R_1 = 10 k (typical)$

6R, the MC6801 ROM has been relocated by a mask option The first 32 locations of each map are reserved for the internal register area, as shown in Table 4, with exceptions as indicated

FIGURE 18 - MC6801/03/03NR MEMORY MAPS

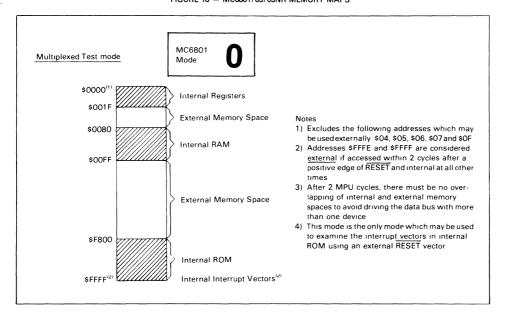


FIGURE 18 - MC6801/03/03NR MEMORY MAPS (CONTINUED)

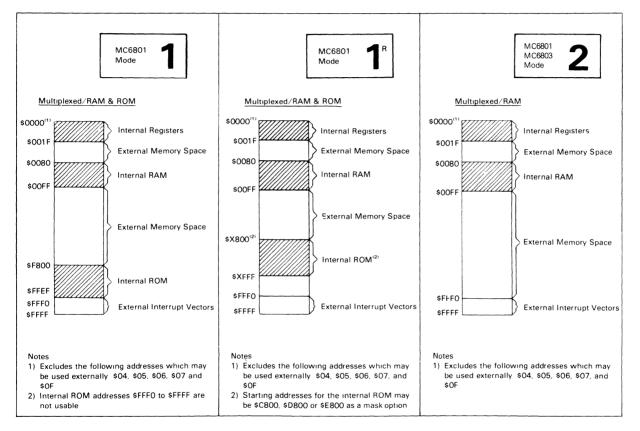


FIGURE 18 - MC6801/03/03NR MEMORY MAPS (CONTINUED)

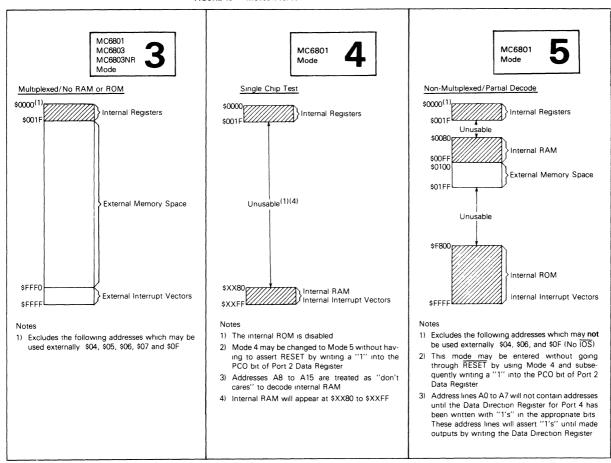
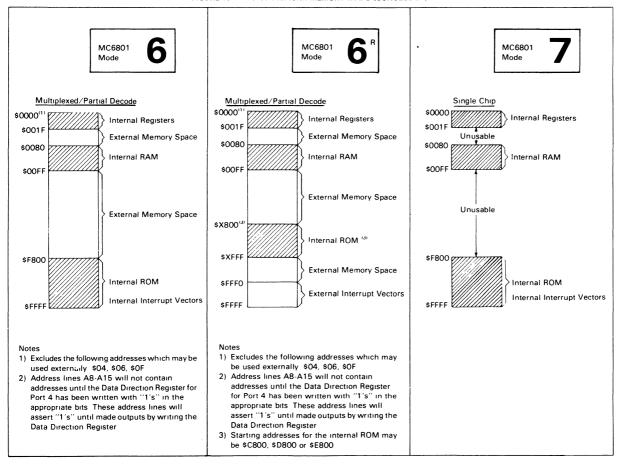


FIGURE 18 - MC6801/03/03NR MEMORY MAPS (CONCLUDED)



MC6801/03/03NR INTERRUPTS

The M6801 Family supports two types of interrupt requests maskable and non-maskable. A Non-Maskable Interrupt (\$\overline{MN}\$) is always recognized and acted upon at the completion of the current instruction. Maskable interrupts are controlled by the Condition Code Register I-bit and by individual enable bits. The I-bit controls all maskable interrupts. Of the maskable interrupts, there are two types \$\overline{RO1}\$ and \$\overline{RO2}\$. The Programmable Timer and Serial Communications Interface use an internal \$\overline{RO2}\$ interrupt tine, as shown in Figure 2 External devices (and IS3) use \$\overline{RO1}\$ an \$\overline{RO1}\$ interrupt is serviced before \$\overline{RO2}\$ if both are pending

All IRQ2 interrupts use hardware prioritized vectors. The single SCI interrupt and three timer interrupts are serviced in a prioritized order and each is vectored to a separate location. All interrupt vector locations are shown in Table 5

The Interrupt flowchart is depicted in Figure 19 and is common to every interrupt excluding reset. During interrupt servicing the Program Counter, Index Register, A Accumulator, B Accumulator, and Condition Code Register are pushed to the stack. The I-bit is set to inhibit maskable interrupts and a vector is fetched corresponding to the current highest priority interrupt. The vector is transferred to the Program Counter and instruction execution is resumed. Interrupt and RESET timing are illustrated in Figures 20 and 21.

FUNCTIONAL PIN DESCRIPTIONS

VCC AND VSS

VCC and VSS provide power to a large portion of the MCU The power supply should provide +5 volts ($\pm5\%$) to VCC, and VSS should be tied to ground. Total power dissipation (including VCC Standby), will not exceed PD milliwatts

VCC STANDBY

VCC Standby provides power to the standby portion (\$80 through \$BF) of the RAM and the STBY PWR and RAME bits of the RAM Control Register Voltage requirements depend on whether the device is in a powerup or powerdown state in the powerup state, the power supply should provide +5 volts (±5%) and must reach VSB volts before RESET reaches 4 0 volts During powerdown, VCC Standby must remain above VSBB (min) to sustain the standby RAM and STBY PWR bit While in powerdown operation, the standby current will not exceed ISBB

It is typical to power both VCC and VCC Standby from the same source during normal operation. A diode must be used

between them to prevent supplying power to VCC during powerdown operation VCC Standby should be tied to ground in Mode 3

TABLE 4 — INTERNAL REGISTER AREA

| Register | Address |
|--|---------|
| Port 1 Data Direction Register*** | 00 |
| Port 2 Data Direction Register *** | 01 |
| Port 1 Data Register | 02 |
| Port 2 Data Register | 03 |
| Port 3 Data Direction Register*** | 04* |
| Port 4 Data Direction Register *** | 05** |
| Port 3 Data Register | 06* |
| Port 4 Data Register | 07** |
| Timer Control and Status Register | 08 |
| Counter (High Byte) | 09 |
| Counter (Low Byte) | 0A |
| Output Compare Register (High Byte) | ОВ |
| Output Compare Register (Low Byte) | ос |
| Input Capture Register (High Byte) | OD |
| Input Capture Register (Low Byte) | 0E |
| Port 3 Control and Status Register | OF* |
| Rate and Mode Control Register | 10 |
| Transmit/Receive Control and Status Register | 11 |
| Receive Data Register | 12 |
| Transmit Data Register | 13 |
| RAM Control Register | 14 |
| Reserved | 15-1F |
| | , |

^{*}External addresses in Modes 0, 1, 2, 3, 5, 6, cannot be accessed in Mode 5 (No $\overline{\text{IOS}}$)

TABLE 5 - MCU INTERRUPT VECTOR LOCATIONS

| MSB | LSB | Interrupt |
|------|------|--------------------------|
| | | |
| FFFE | FFFF | RESET |
| FFFC | FFFD | NMI |
| FFFA | FFFB | Software Interrupt (SWI) |
| FFF8 | FFF9 | IRQ1 (or IS3) |
| FFF6 | FFF7 | ICF (Input Capture)* |
| FFF4 | FFF5 | OCF (Output Compare)* |
| FFF2 | FFF3 | TOF (Timer Overflow)* |
| FFF0 | FFF1 | SCI (RDRF+ORFE+TDRE)* |

^{*}IRQ2 Interrupt

^{**}External addresses in Modes 0, 1, 2, 3

^{***1 =} Output, 0 = Input

FIGURE 19 - INTERRUPT FLOWCHART

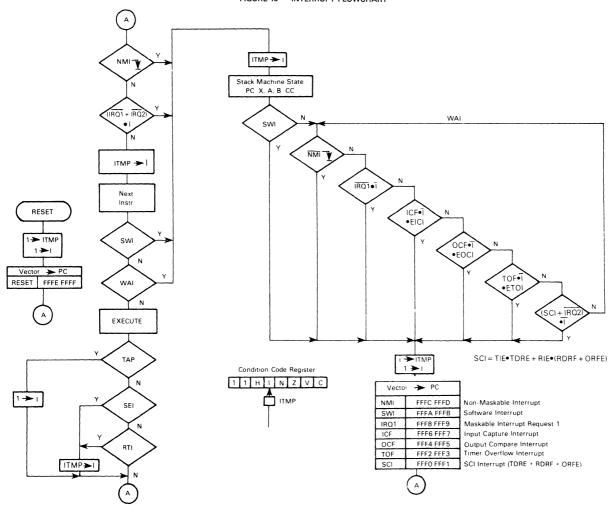


FIGURE 20 - INTERRUPT SEQUENCE

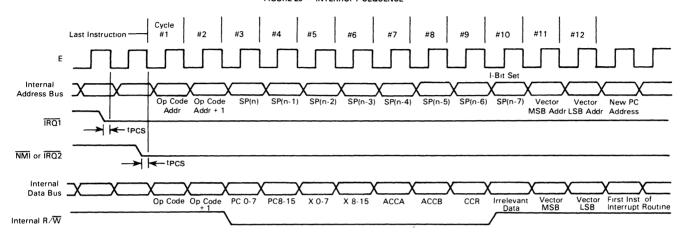
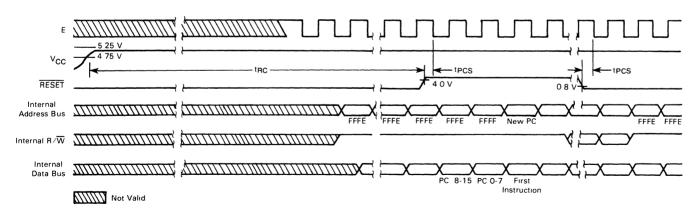


FIGURE 21 - RESET TIMING



MC6801 • MC6803 • MC6803 NR

XTAL1 AND EXTAL2

These two input pins interface either a crystal or TTL compatible clock to the MCU internal clock generator. Divide-byfour circuitry is included which allows use of the inexpensive 358 MHz or 4 4336 MHz Color Burst TV crystals. A 20 pF capacitor should be tied from each crystal pin to ground to ensure reliable startup and operation. Alternatively, EXTAL2 may be driven by an external TTL compatible clock at $4f_0$ with a duty cycle of 50% ($\pm5\%$) with XTAL1 connected to ground

The internal oscillator is designed to interface with an AT-cut quartz crystal resonator operated in parallel resonance mode in the frequency range specified for $f_{\rm XTAL}$. The crystal should be mounted as close as possible to the input pins to minimize output distortion and startup stabilization time $^{\bullet}$. The MCU is compatible with most commercially available crystals. Nominal crystal parameters are shown in Figure 22.

RESET

This input is used to reset the internal state of the device and provide an orderly startup procedure. During powerup, RESET must be held below 0.8 volts. (1) at least tRC after VCC reaches 4.75 volts in order to provide sufficient time for the clock generator to stabilize, and (2) until VCC Standby reaches 4.75 volts. RESET must be held low at least three E-cycles if asserted during powerup operation.

E (ENABLE)

This is an output clock used primarily for bus synchronization. It is TTL compatible and is the slightly skewed divide-by-four result of the device input clock frequency. It will drive one Schottky TTL load and 90 pF, and all data given in cycles is referenced to this clock unless otherwise noted.

NMI (NON-MASKABLE INTERRUPT)

An $\overline{\text{NMI}}$ negative edge requests an MCU interrupt sequence, but the current instruction will be completed before it responds to the request. The MCU will then begin an interrupt sequence. Finally, a vector is fetched from \$FFFC and \$FFFD, transferred to the Program Counter and instruction execution is resumed. $\overline{\text{NMI}}$ typically requires a 3.3 k Ω (nominal) resistor to VCC. There is no internal $\overline{\text{NMI}}$ pullup resistor. $\overline{\text{NMI}}$ must be held low for at least one E-cycle to be recognized under all conditions.

IRQ1 (MASKABLE INTERRUPT REQUEST 1)

IRQ1 is a level-sensitive input which can be used to request an interrupt sequence. The MPU will complete the current instruction before it responds to the request. If the interrupt mask bit (I-bit) in the Condition Code Register is clear, the MCU will begin an interrupt sequence. A vector is fetched from \$FFF8 and \$FFF9, transferred to the Program Counter, and instruction execution is resumed.

 $\overline{IRO1}$ typically requires an external 3.3 k Ω (nominal) resistor to VCC for wire-OR applications $\overline{IRO1}$ has no internal pullup resistor

SC1 AND SC2 (STROBE CONTROL 1 AND 2)

The function of SC1 and SC2 depends on the operating mode. SC1 is configured as an output in all modes except single chip mode, whereas SC2 is always an output SC1 and SC2 can drive one Schottky load and 90 pF

SC1 and SC2 In Single-Chip Mode

In Single-Chip Mode, SC1 and SC2 are configured as an input and output, respectively, and both function as Port 3 control lines SC1 functions as $\overline{1S3}$ and can be used to indicate that Port 3 input data is ready or output data has been accepted. Three options associated with $\overline{1S3}$ are controlled by Port 3 Control and Status Register and are discussed in the Port 3 description. If unused, $\overline{1S3}$ can remain unconnected

SC2 is configured as $\overline{OS3}$ and can be used to strobe output data or acknowledge input data. It is controlled by Output Strobe Select (OSS) in the Port 3 Control and Status Register. The strobe is generated by a read (OSS=0) or write (OSS=1) to the Port 3 Data Register.

SC1 And SC2 In Expanded Non-Multiplexed Mode

In the Expanded Non-Multiplexed Mode, both SC1 and SC2 are configured as outputs SC1 functions as Input/Output Select (IOS) and is asserted only when \$0100 through \$01FF is sensed on the internal address bus

SC2 is configured as Read/Write and is used to control the direction of data bus transfers. An MPU read is enabled when Read/Write and E are high

SC1 And SC2 In Expanded Multiplexed Mode

In the Expanded Multiplexed Modes, both SC1 and SC2 are configured as outputs SC1 functions as Address Strobe and can be used to demultiplex the eight least significant addresses and the data bus A latch controlled by Address Strobe captures address on the negative edge, as shown in Figure 15

SC2 is configured as Read/Write and is used to control the direction of data bus transfers. An MPU read is enabled when Read/Write and E are high

P10-P17 (PORT 1)

Port 1 is a mode independent 8-bit I/O port with each line an input or output as defined by the Port 1 Data Direction Register The TTL compatible three-state output buffers can drive one Schottky TTL load and 30 pF, Darlington transistors, or CMOS devices using external pullup resistors. It is configured as a data input port by RESET. Unused lines can remain unconnected

P20-P24 (PORT 2)

Port 2 is a mode-independent, 5-bit, multipurpose I/O port The voltage levels present on P20, P21, and P22 on the rising edge of RESET determine the operating mode of the MCU The entire port is then configured as a data input port. The Port 2 lines can be selectively configured as data output lines by setting the appropriate bits in the Port 2 Data Direction. Register. The Port 2 Data Register is used to move data through the port. However, if P21 is configured as an output, it will be tied to the timer Output Compare function and cannot be used to provide output from the Port. 2 Data Register.

Port 2 can also be used to provide an interface for the Serial Communications Interface and the timer Input Edge function. These configurations are described in the appropriate SCI and Timer sections of this publication.

The Port 2 three-state, TTL-compatible output buffers are capable of driving one Schottky TTL load and 30 pF, or CMOS devices using external pullup resistors

PORT 2 DATA REGISTER

| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | |
|-----|-----|-----|-----|-----|-----|-----|-----|--------|
| PC2 | PC1 | PC0 | P24 | P23 | P22 | P21 | P20 | \$0003 |

Devices made with masks subsequent to M5G, M8D and T5P incorporate an advanced clock with improved startup characteristics

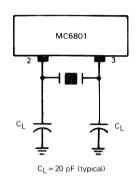
FIGURE 22 - M6801 FAMILY OSCILLATOR CHARACTERISTICS

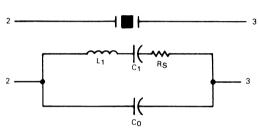
(a) Nominal Recommended Crystal Parameters

Nominal Crystal Parameters*

| | 3.58 MHz | 4.00 MHz | 5.0 MHz | 6.0 MHz | 8.0 MHz |
|----------------|----------|----------|--------------|--------------|--------------|
| RS | 60 Ω | 50 Ω | 30-50 Ω | 30-50 Ω | 20-40 Ω |
| C ₀ | 35 pF | 65 pF | 4-6 pF | 4-6 pF | 4-6 pF |
| C ₁ | 0 015 pF | 0 025 pF | 0 01-0 02 pF | 0 01-0 02 pF | 0 01-0 02 pF |
| Q | >40 K | >30 K | > 20 K | >20 K | >20 K |

*NOTE These are representative AT-cut crystal parameters only. Crystals of other types of cut may also be used



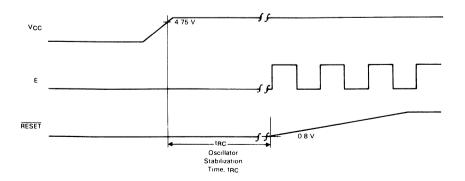


Equivalent Circuit

NOTE TTL-compatible oscillators may be

obtained from
Motorola Component Products
Attn Data Clock Sales
2553 N Edgington St
Franklin Park, IL 60131
Tel 312-451-1000
Telex 433-0067

(b) Oscillator Stabilization Time (tRC)



P30-P37 (PORT 3)

7

Port 3 can be configured as an I/O port, a bidirectional 8-bit data bus, or a multiplexed address/data bus depending on the operating mode. The TTL compatible three-state outout buffers can drive one Schottky TTL load and 90 pF Unused lines can remain unconnected

Port 3 In Single-Chip Mode

5 Δ

Port 3 is an 8-bit I/O port in the Single-Chip Mode, with each line configured by the Port 3 Data Direction Register There are also two lines, $\overline{1S3}$ and $\overline{0S3}$, which can be used to control Port 3 data transfers

Three Port 3 options are controlled by the Port 3 Control and Status Register and are available only in Single-Chip Mode (1) Port 3 input data can be latched using 1S3 as a control signal, (2) OS3 can be generated by either an MPU read or write to the Port 3 Data Register, and (3) an IRQ1 interrupt can be enabled by an IS3 negative edge Port 3 latch timing is shown in Figure 6

PORT 3 CONTROL AND STATUS REGISTER 3

2 1

| , | | | | | | | | _ |
|-------------|-----------------------|---|--|--|---|---|---|--|
| IS3 Flag | IS3 IRQ1 Enable | × | oss | Latch Enable | × | X | × | \$000F |
| Bit 0-Bit 3 | 2 | | LAT input is later later Port BLE OSS dete general Stroll set, | t latch for the content of the conte | or Por y an IS: sparer Regised dur ut Stro whet y a rea gister enerated | t 3 If 3 negant after ster Lang repobe Secher idea wheeld by a language of the secher | set, in itive ed r a rea ATCH set elect) OS3 rite of en cle a read | trols the put data dge The dof the ENAL-This bit will be the Portear, the d, when OSS is |
| Bit 5 | | | Not | used | _ | | | |
| Bit 6 | | | ınter FLA | rupt wil G is set hibited | l be er , wher | nabled n clear | when | an IRQ1 lever IS3 interrupt d during |
| Bit 7 | | | set clea | by an red by a | īS3 n read (| egativ | e edg Port 3 | tus bit is ge It is 3 Control 3 FLAG |

Port 3 In Expanded Non-Multiplexed Mode

Port 3 is configured as a bidirectional data bus (D7-D0) in the Expanded Non-Multiplexed Mode. The direction of data transfers is controlled by Read/Write (SC2) Data is clocked by E (Enable)

set) followed by a read or write to the Port 3 Data Register or during reset

Port 3 In Expanded Multiplexed Mode

Port 3 is configured as a time multiplexed address (A0-A7) and data bus (D7-D0) in the Expanded Multiplexed Modes, where Address Strobe (AS) can be used to demultiplex the two buses. Port 3 is held in a high impedance state between valid address and data to prevent bus conflicts

P40-P47 (PORT 4)

Port 4 is configured as an 8-bit I/O port, as address outputs, or as data inputs depending on the operating mode Port 4 can drive one Schottky TTL load and 90 pF and is the only port with internal pullup resistors. Unused lines can remain unconnected

Port 4 In Single-Chip Mode

In Single-Chip Mode, Port 4 functions as an 8-bit I/O port with each line configured by the Port 4 Data Direction Register Internal pullup resistors allow the port to directly interface with CMOS at 5 volt levels External pullup resistors to more than 5 volts, however, cannot be used

Port 4 In Expanded Non-Multiplexed Mode

Port 4 is configured from reset as an 8-bit input port, where the Port 4 Data Direction Register can be written to provide any or all of eight address lines. A0 to A7 Internal pullup resistors pull the lines high until the Port 4 Data Direction Register is configured

Port 4 In Expanded Multiplexed Mode

In all Expanded Multiplexed modes except Mode 6, Port 4 functions as half of the address bus and provides A8 to A15 In Mode 6, the port is configured from reset as an 8-bit parallel input port, where the Port 4 Data Direction Register can be written to provide any or all of upper address lines A8 to A15 Internal pullup resistors pull the lines high until the Port 4 Data Direction Register is configured, where bit 0 controls A8

RESIDENT MEMORY

The MC6801 provides 2048 bytes of on-board ROM and 128 bytes of on-board RAM

One half of the RAM is powered through the VCC standby pin and is maintainable during VCC powerdown. This standby portion of the RAM consists of 64 bytes located from \$80 through \$BF

Power must be supplied to VCC standby if the internal RAM is to be used regardless of whether standby power operation is anticipated

The RAM is controlled by the RAM Control Register

RAM CONTROL REGISTER (\$14)

The RAM Control Register includes two bits which can be used to control RAM accesses and determine the adequacy of the standby power source during powerdown operation It is intended that RAME be cleared and STBY PWR be set as part of a powerdown procedure

RAM CONTROL REGISTER

| | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---|------|------|---|---|---|---|---|---|
| ſ | STBY | RAME | X | X | Х | X | Х | Х |
| Ì | PWR | | | | | | | |

Bit 0-5 Not Used

Bit 6 RAME

RAM Enable This Read/Write bit can be used to remove the entire RAM from the internal memory map RAME is set (enabled) during Reset provided standby power is available on the positive edge of RESET If RAME is clear, any access to a RAM address is external. If RAME is set and not in Mode 3, the RAM is included in the internal map

Bit 7 STBY PWR

Standby Power This bit is a Read/Write status bit which is cleared whenever V_{CC} Standby decreases below V_{SBB} (min) It can be set only by software and is not affected during reset

PROGRAMMABLE TIMER

The Programmable Timer can be used to perform input waveform measurements while independently generating an output waveform Pulse widths can vary from several microseconds to many seconds A block diagram of the Timer is shown in Figure 23

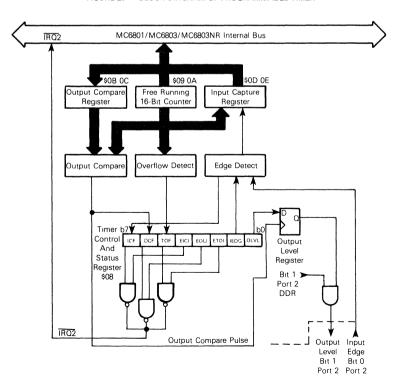
COUNTER (\$09:0A)

The key timer element is a 16-bit free-running counter which is incremented by E (Enable). It is cleared during reset and is read-only with one exception, a write to the counter (\$09) will preset it to \$FFF8. This feature, intended for testing, can disturb serial operations because the counter provides the SCI internal bit rate clock. TOF is set whenever the counter contains all 1's.

OUTPUT COMPARE REGISTER (\$0B:0C)

The Output Compare Register is a 16-bit Read/Write register used to control an output waveform or provide an arbitrary timeout flag. It is compared with the free-running counter on each E-cycle. When a match occurs, OCF is set

FIGURE 23 - BLOCK DIAGRAM OF PROGRAMMABLE TIMER



and OLVL is clocked to an output level register. If Port 2, bit 1, is configured as an output, OLVL will appear at P21 and the Output Compare Register and OLVL can then be changed for the next compare. The function is inhibited for one cycle after a write to its high byte (\$0B) to ensure a valid compare. The Output Compare Register is set to \$FFFF at RESET.

INPUT CAPTURE REGISTER (\$0D:0E)

The Input Capture Register is a 16-bit read-only register used to store the free-running counter when a "proper" input transition occurs as defined by IEDG. Port 2, bit 0 should be configured as an input, but the edge detect circuit always senses P20 even when configured as an output. An input capture can occur independently of ICF, the register always contains the most current value. Counter transfer is inhibited, however, between accesses of a double byte MPU read. The input pulse width must be at least two E-cycles to ensure an input capture under all conditions.

TIMER CONTROL AND STATUS REGISTER (\$08)

The Timer Control and Status Register (TCSR) is an 8-bit register of which all bits are readable, while only bits 0-4 can be written. The three most significant bits provide the timer status and indicate if:

- · a proper level transition has been detected,
- a match has occured between the free-running counter and the output compare register, and
- the free-running counter has overflowed

Each of the three events can generate an $\overline{\text{IRO2}}$ interrupt and is controlled by an individual enable bit in the TCSR

TIMER CONTROL AND STATUS REGISTER (TCSR)

| , | O | 5 | 4 | 3 | 2 | ' | U | |
|-------|------|-----|--------------------|---------------------------------------|---------------------------------------|--------------------------------------|--------------------------------------|---|
| ICF | OCF | TOF | EICI | EOCI | ETOI | IEDG | OLVL | \$0008 |
| Bit 0 | OLVL | | out out if I | put le put co 3 t 1 c gister | evel re ompare of the | gister and Port | by a will app 2 Data | ked to the successful pear at P21 Direction red during |
| Bit 1 | EIDG | | res tion the | et and n will input OG=0 | l conti triggei Capti Transi | rols w r a co ure Re fer on | hich le unter gister a nega | ed during evel transi- transfer to ative-edge tive-edge |
| Bit 2 | ETOI | | Wh for inte | nen set a tim | t, an IF er ove | RQ2 in rflow, | terrupt when | Interrupt is enabled clear, the eared dur- |
| Bit 3 | EOCI | | Wł for | nen set an o | t, an IF utput | RQ2 in comp | terrupt are, w | Interrupt is enabled hen clear, is cleared |

during reset

| Bit 4 EICI | Enable Input Capture Interrupt When |
|------------|--|
| | set, an IRQ2 interrupt is enabled for an |
| | input capture, when clear, the inter- |
| | rupt is inhibited. It is cleared during |
| | reset |

Bit 5 TOF Timer Overflow Flag TOF is set when the counter contains all 1's It is cleared by reading the TCSR (with TOF set) then reading the counter high

byte (\$09), or during reset

Bit 6 OCF Output Compare Flag OC

Output Compare Flag OCF is set when the Output Compare Register matches the free-running counter. It is cleared by reading the TCSR (with OCF set) and then writing to the Output Compare Register (\$0B or \$0C), or during reset

Bit 7 ICF Input Capture Flag ICF is set to in-

dicate a proper level transition, it is cleared by reading the TCSR (with ICF set) and then the Input Capture Register High Byte (\$0D), or during

reset

SERIAL COMMUNICATIONS INTERFACE (SCI)

A full-duplex asynchronous Serial Communications Interface (SCI) is provided with two data formats and a variety of rates. The SCI transmitter and receiver are functionally independent, but use the same data format and bit rate. Serial data formats include standard mark/space (NRZ) and Biphase and both provide one start bit, eight data bits, and one stop bit. "Baud" and "bit rate" are used synonymously in the following description.

WAKE-UP FEATURE

In a typical serial loop multi-processor configuration, the software protocol will usually identify the addressee(s) at the beginning of the message. In order to permit uninterested MPU's to ignore the remainder of the message, a wake-up feature is included whereby all further SCI receiver flag (and interrupt) processing can be inhibited until its data line goes idle. An SCI receiver is re-enabled by an idle string of ten consecutive 1's or during reset. Software must provide for the required idle string between consecutive messages and prevent it within messages.

PROGRAMMABLE OPTIONS

The following features of the SCI are programmable

- format standard mark/space (NRZ) or Bi-phase
- clock external or internal bit rate clock
- Baud one of 4 per E-clock frequency, or external clock (×8 desired baud)
- wake-up feature enabled or disabled
- Interrupt requests enabled individually for transmitter and receiver
- clock output internal bit rate clock enabled or disabled to P22

SERIAL COMMUNICATIONS REGISTERS

The Serial Communications Interface includes four addressable registers as depicted in Figure 24. It is controlled by the Rate and Mode Control Register and the Transmit/Receive Control and Status Register Data is transmitted and received utilizing a write-only Transmit Register and a read-only Receive Register. The shift registers are not accessible to software.

Rate and Mode Control Register (RMCR) (\$10)

The Rate and Mode Control Register controls the SCI bit rate, format, clock source, and under certain conditions, the configuration of P22. The register consists of four write-only bits which are cleared during reset. The two least significant bits control the bit rate of the internal clock and the remaining two bits control the format and clock source.

RATE AND MODE CONTROL REGISTER (RMCR)

| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | |
|---|---|---|---|-----|-----|-----|-----|--------|
| Х | Х | Χ | Х | CC1 | CC0 | SS1 | SS0 | \$0010 |

Bit 1 Bit 0

SS1 SS0 Speed Select These two bits select the Baud when using the internal clock Four rates may be selected which are a function of the MCU input frequency Table 6 lists bit time and rates for three selected MCU frequencies

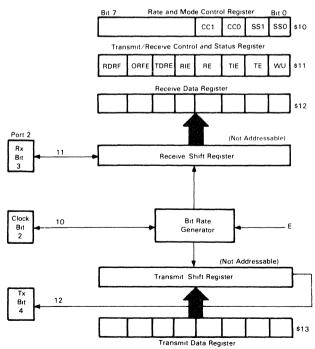
Bit 3 Bit 2

CC1 CC0 Clock Control and Format Select These two bits control the format and select the serial clock source If CC1 is set, the DDR value for P22 is forced to the complement of CC0 and cannot be altered until CC1 is cleared If CC1 is cleared after having been set, its DDR value is unchanged Table 7 defines the formats, clock source, and use of P22

If both CC1 and CC0 are set, an external TTL compatible clock must be connected to P22 at eight times (8X) the desired bit rate, but not greater than E, with a duty cycle of 50% (\pm 10%) If CC1 CC0=10, the internal bit rate clock is provided at P22 regardless of the values for TE or RE

NOTE: The source of SCI internal bit rate clock is the timer free running counter. An MPU write to the counter can disturb serial operations.

FIGURE 24 - SCI REGISTERS



Transmit/Receive Control And Status Register (TRCSR) (\$11)

The Transmit/Receive Control and Status Register controls the transmitter, receiver, wake-up feature, and two individual interrupts and monitors the status of serial operations. All eight bits are readable while bits 0 to 4 are also writable The register is initialized to \$20 by RESET

TRANSMIT/RECEIVE CONTROL AND STATUS REGISTER (TRCSR)

7 6 5 2 4 3 1 Ω rdrforfeltdre RIE WU \$0011 RE TIE TE

Bit 0 WU "Wake-up" on Idle Line When set, WU enables the wake-up function, it is cleared by ten consecutive 1's or during reset WU will not set if the line is ıdle

Bit 1 TE Transmit Enable When set, P24 DDR bit is set, cannot be changed, and will remain set if TE is subsequently cleared When TE is changed from clear to set, the transmitter is connected to P24 and a preamble of nine consecutive 1's is transmitted TE is

cleared during reset

Bit 2 TIE Transmit Interrupt Enable When set, an IRQ2 interrupt is enabled when TDRE is set, when clear, the interrupt is inhibited. TE is cleared during reset Bit 3 RE Receive Enable When set, the P23 DDR bit is cleared, cannot be changed, and will remain clear if RE is subsequently cleared While RE is set, the

SCI receiver is enabled RE is cleared during reset

Bit 4 RIE

Receiver Interrupt Enable When set, an IRQ2 interrupt is enabled when RDRF and/or ORFE is set, when clear, the interrupt is inhibited RIE is cleared during reset

Bit 5 TDRE

Transmit Data Register Empty TDRE is set when the Transmit Data Register is transferred to the output serial shift register or during reset. It is cleared by reading the TRCSR (with TDRE set) and then writing to the Transmit Data Register Additional data will be transmitted only if TDRE has been cleared

Bit 6 ORFF

Bit 7 RDRF

Overrun Framing Error If set, ORFE indicates either an overrun or framing error An overrun is a new byte ready to transfer to the Receiver Data Register with RDRF still set. A receiver framing error has occurred when the byte boundaries of the bit stream are not synchronized to the bit counter. An overrun can be distinguished from a framing error by the state of RDRF if RDRF is set, then an overrun has occurred, otherwise a framing error has been detected. Data is not transferred. to the Receive Data Register in an overrun condition Unframed data causing a framing error is transferred to the Receive Data Register However, subsequent data transfer is blocked until the framing error flag is cleared * ORFE is cleared by reading the TRCSR (with ORFE set) then the Receive Data Register, or during reset Receive Data Register Full RDRF is set when the input serial shift register is transferred to the Receive Data Register It is cleared by reading the TRCSR (with RDRF set), and then the Receive Data Register, or during reset

TABLE 6 - SCI BIT TIMES AND RATES

| SS1:SS0 | | 4f _O 2.4576 MHz | | 4.0 Mhz | 4.9152 MHz | | |
|-----------------|---|----------------------------|---------------------|---------------------|---------------------|--|--|
| | | E | 614.4 kHz | 1.0 MHz | 1.2288 MHz | | |
| 0 | 0 | - 16 | 26 μs/38,400 Baud | 16 μs/62,500 Baud | 13 0 μs/76,800 Baud | | |
| 0 | 1 | 128 | 208 μs/4,800 baud | 128 μs/7812 5 Baud | 104 2 μs/9,600 Baud | | |
| 1 | 0 | - 1024 | 1 67 ms/600 Baud\$ | 1 024 ms/976 6 Baud | 833 3 μs/1,200 Baud | | |
| 1 | 1 | - 4096 | 6 67 ms/150 Baud | 4 096 ms/244 1 Baud | 3 33 ms/300 Baud | | |
| *External (P22) | | (P22) | 13 0 μs/76,800 Baud | 8 0 μs/125,000 Baud | 6 5 μs/153,600 Baud | | |

^{*}Using maximum clock rate

TABLE 7 - SCI FORMAT AND CLOCK SOURCE CONTROL

| | CC1:CC0 | Format | Clock Source | Port 2 Bit 2 |
|---|---------|----------|-----------------|-----------------|
| | 00 | Bı-Phase | Internal | Not Used |
| | 01 | NRZ | Internal | Not Used |
| ı | 10 | NRZ | Internal | Output |
| | 11 | NRZ | External | Input |

^{*}Devices made with mask numbers M5G, M8D, and T5P do not transfer unframed data to the Receive Data Register

SERIAL OPERATIONS

The SCI is initialized by writing control bytes first to the Rate and Mode Control Register and then to the Transmit/Receive Control and Status Register. When TE is set, the output of the transmit serial shift register is connected to P24 and serial output is initiated by transmitting a 9-bit preamble of 1's

At this point one of two situations exist 1) if the Transmit Data Register is empty (TDRE=1), a continuous string of 1's will be sent indicating an idle line, or 2) if a byte has been written to the Transmit-Data Register (TDRE=0), it will be transferred to the output serial shift register (synchronized with the bit rate clock), TDRE will be set, and transmission will begin

The start bit (0), eight data bits (beginning with bit 0) and a stop bit (1), will be transmitted. If TDRE is still set when the next byte transfer should occur, 1's will be sent until more data is provided. In Bi-phase format, the output toggles at the start of each bit and at half-bit time when a "1" is sent. Receive operation is controlled by RE which configures P23 as an input and enables the receiver. SCI data formats are illustrated in Figure 25.

INSTRUCTION SET

The MC6801/03/03NR is upward source and object code compatible with the MC6800 Execution times of key instructions have been reduced and several new instructions have been added, including a hardware multiply A list of new operations added to the MC6800 instruction set is shown in Table 1

In addition, two new special opcodes, 4E and 5E, are provided for test purposes. These opcodes force the Program Counter to increment like a 16-bit counter, causing address lines used in the expanded modes to increment until the device is reset. These opcodes have no mnemonics.

The coding of the first (or only) byte corresponding to an

executable instruction is sufficient to identify the instruction and the addressing mode. The hexadecimal equivalents of the binary codes, which result from the translation of the 82 instructions in all valid modes of addressing, are shown in Table 8. There are 220 valid machine codes, 34 unassigned codes, and 2 codes reserved for test purposes.

PROGRAMMING MODEL

A programming model for the MC6801/03/03NR is shown in Figure 11. Accumulator A can be concatenated with accumulator B and jointly referred to as accumulator D where A is the most significant byte. Any operation which modifies the double accumulator will also modify accumulator A and/or B. Other registers are defined as follows.

Program Counter — The program counter is a 16-bit register which always points to the next instruction

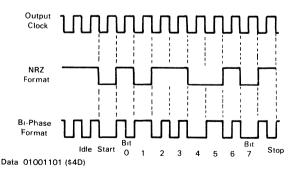
Stack Pointer — The stack pointer is a 16-bit register which contains the address of the next available location in a pushdown/pullup (LIFO) queue. The stack resides in random access memory at a location defined by the programmer.

Index Register — The Index Register is a 16-bit register which can be used to store data or provide an address for the indexed mode of addressing

Accumulators — The MPU contains two 8-bit accumulators, A and B, which are used to store operands and results from the arithmetic logic unit (ALU) They can also be concatenated and referred to as the D (double) accumulator

Condition Code Registers — The condition code register indicates the results of an instruction and includes the following five condition bits. Negative (N), Zero (Z), Overflow (V), Carry/Borrow from MSB (C), and Half Carry from bit 3 (H). These bits are testable by the conditional branch instructions. Bit 4 is the interrupt mask (I-bit) and inhibits all maskable interrupts when set. The two unused bits, B6 and B7, are read as ones.

FIGURE 25 - SCI DATA FORMATS



ADDRESSING MODES

Six addressing modes can be used to reference memory A summary of addressing modes for all instructions is presented in Tables 9, 10, 11, and 12, where execution times are provided in E-cycles Instruction execution times are summarized in Table 13. With an input frequency of 4 MHz, E-cycles are equivalent to microseconds. A cycle-by-cycle description of bus activity for each instruction is provided in Table 14 and a description of selected instructions is shown in Figure 26.

Immediate Addressing — The operand or "immediate byte(s)" is contained in the following byte(s) of the instruction where the number of bytes matches the size of the register. These are two or three byte instructions

Direct Addressing — The least significant byte of the operand address is contained in the second byte of the instruction and the most significant byte is assumed to be \$00 Direct addressing allows the user to access \$00 through \$FF using two byte instructions and execution time is reduced by eliminating the additional memory access. In most applica-

tions, the 256-byte area is reserved for frequently referenced data

Extended Addressing — The second and third bytes of the instruction contain the absolute address of the operand These are three byte instrutions

Indexed Addressing — The unsigned offset contained in the second byte of the instruction is added with carry to the Index Register and used to reference memory without changing the Index Register. These are two byte instructions

Inherent Addressing — The operand(s) are registers and no memory reference is required. These are single byte instructions

Relative Addressing — Relative addressing is used only for branch instructions. If the branch condition is true, the Program Counter is overwritten with the sum of a signed single byte displacement in the second byte of the instruction and the current Program Counter. This provides a branch range of — 126 to 129 bytes from the first byte of the instruction. These are two byte instructions.

MNEM DES MNEM CPX MODE MNEM MODE ~ MNEM MODE MNEM MODE MODE 68 ASI DXD 01 NOP INHER 35 TXS ROL 9D 9E ICD nı CNAPE 02 D2 36 PSHA 64 DEC 6 LDS DIR ADDD 03 04 05 06 07 08 09 0A 0B 0C 0D 0E 0F PSHB 6B STS DЗ LSRD 40 SUBA D4 ANDB 38 PULX 60 INC ASID 39 3A RTS CMPA D5 RITR LDAB SBCA ABX 6E IMP TPA 3B 3C RTI 10 4 10 CLR INDXD EXTND Α3 SUBD D7 STAB INX EORB ADCB PSHX ANDA D8 70 NEG D9 าก MIII 71 72 Α5 RITA A6 A7 A8 A9 LDAA DA ORAR 9 12 OB ADDB SEV 3F SWI 73 74 COM STAA CLC NEGA EORA ADCA I DD LSR STD DD 41 75 76 CLI AA AB ROR ORAA DE LDX SIX 43 COMA 77 ASR ADDA SBA 78 AC AD CPX JSR EΩ SHBB 10 11 12 13 LSRA ASL CBA CMPB 45 79 RO RORA DEC AE AF i DS F 2 SBCB 7B 7C 7D INDXD ADDD ASRA STS 48 49 4A 14 ASLA INC RΩ SUBA ANDB 15 CMPA вітв ROLA TST JMP 16 17 TAB DECA SBCA E6 LDAB TBA 48 STAR EXTND SUBD CLR 80 E8 EORB 18 19 1A 1B 1C 1D 1E 4C 4D INCA SUBA IMMED 84 ANDA DAA INHER 2 TSTA CMPA BITA ADCE ORAB 4E 4F 82 SRCA 86 LDAA B7 B8 ABA INHER 2 83 STAA EB Anne SUBD EORA LDD 50 NEGB 84 ANDA ADCA 85 BITA 89 8A ED STD DX 52 LDAA 16 53 54 55 56 сомв 87 88 вв ADDA STX INDXD 20 SUBB BRA EORA LSRB 21 22 BRN 89 8A ADCA ORAA ВD JSR CMPB BE BF LDS SBCB ADDD ВНІ RORB EXTND BUS 8B 8C 23 24 25 26 27 28 29 2A 2B 57 58 ASRR ΔΠΠΔ STS BCC CPX IMMED co SUBB CMPB ANDB ASLB вітв BCS 59 5A ROLE 8D RSR BEL LDS SACR LDAR 88 DECB STAB ADDD 5B 5C BEO 90 SUBA ANDB F8 FORB 5D 5E 5F BVS TSTR 91 CMPA BPL 92 SBCA C6 LDAB ORAB ADDE CLRB INHER 2 93 SUBD 2C 2D BGE INDXD 94 95 C 8 FORR I DD 2 2 2 1 NEG STD FD BLT 61 BITA 2E 2F 30 31 BGT 96 97 LDAA CA ORAB LDX 3 63 64 65 ADDB SIX EXTNO BLE STAA COM TSX 98 99 EORA CC LDD LSR CD CD INS ADCA UNDEFINED OF CODE LDX IMMED 32 33 BOB ORAA INDXD PULB ADDA ASR

TABLE 8 - CPU INSTRUCTION MAP

NOTES

1 Addressing Modes

INHER = Inherent INDXD = Indexed IMME REL = Relative EXTND = Extended DIR =

IMMED = Immediate
DIR = Direct

² Unassigned opcodes are indicated by "*" and should not be executed

³ Codes marked by "T" force the PC to function as a 16-bit counter

TABLE 9 - INDEX REGISTER AND STACK MANIPULATION INSTRUCTIONS

| | | | | | | | | | | | | | | | | | | C | Con | ditio | on (| Cod | es |
|------------------------|----------|----|----|----|----|-----|----|----|-----|---|----|-----|----|-----|-----|-----|------------------------|---|-----|-------|------|-----|----|
| | | In | nm | ed | D | ire | ct | 1 | nde | × | E | xtr | nd | Int | ner | ent | t | 5 | 4 | 3 | 2 | 1 | 0 |
| Pointer Operations | Mnemonic | OP | - | # | OP | ~ | # | OP | ~ | # | OP | ~ | # | OP | ~ | # | Boolean / | Н | T | N | Z | V | С |
| | | | L | | | L | L | _ | L | L | | L | L | | L | L | Arithmetic Operation | 丄 | L | L | L | L | L |
| Compare Index Reg | CPX | 8C | 4 | 3 | 9C | 5 | 2 | AC | 6 | 2 | BC | 6 | 3 | | L | | X - M M + 1 | • | • | ł | 1 | 1 | 1 |
| Decrement Index Reg | DEX | | | | | | | | | | | | | 09 | 3 | 1 | X - 1 - - X | | • | • | 1 | • | • |
| Decrement Stack Pntr | DES | | Г | Π | | | | | | Γ | | Π | | 34 | 3 | 1 | SP - 1 -SP | • | | | • | • | • |
| Increment Index Reg | INX | | | Г | | Г | | | | Г | | | Г | 08 | 3 | 1 | X + 1X | | • | • | T | • | • |
| Increment Stack Pntr | INS | П | Γ | Г | Г | Г | | | | | | | Г | 31 | 3 | 1 | 1 SP + 1 SP | | • | • | • | • | • |
| Load Index Reg | LDX | CE | 3 | 3 | DE | 4 | 2 | EE | 5 | 2 | FE | 5 | 3 | | | | MXH, (M + 1)XL | | • | 1 | | R | • |
| Load Stack Pntr | LDS | 8E | 3 | 3 | 9E | 4 | 2 | ΑE | 5 | 2 | BE | 5 | 3 | | | | M → SPH, (M + 1) → SPL | | • | 1 | П | R | • |
| Store Index Reg | STX | | Г | Γ | DF | 4 | 2 | EF | 5 | 2 | FF | 5 | 3 | | | Г | XH M, XL (M + 1) | • | | 1 | 1 | R | • |
| Store Stack Pntr | STS | | Γ | Γ | 9F | 4 | 2 | AF | 5 | 2 | BF | 5 | 3 | | | | SPH -M, SPL -(M + 1) | | | 1 | | R | • |
| Index Reg → Stack Pntr | TXS | | | Γ | | Г | | | | | | | | 35 | 3 | 1 | X - 1 SP | | | • | • | | • |
| Stack Pntr → Index Reg | TSX | | Γ | Г | | | | | | | | | | 30 | 3 | 1 | SP + 1X | | • | | • | • | • |
| Add | ABX | | | | | | | | | | | | | ЗА | 3 | 1 | B + X -►X | | | | | | |
| Push Data | PSHX | | Г | Г | | | П | | | | | | | 3C | 4 | 1 | XL -MSP, SP - 1 -SP | | | • | | 0 | |
| | | | L | L | _ | L | | | | | | | L | | | | XH -MSP SP - 1 -SP | L | | L | | | |
| Pull Data | PULX | | | | | | | | | | | | | 38 | 5 | 1 | SP + 1 -SP, MSP -XH | | • | • | • | • | • |
| | [| | ١ | 1 | 1 | 1 | | | | | | | | | | | SP + 1 SP, MSP XL | 1 | 1 | | | | ١ |

TABLE 10 - ACCUMULATOR AND MEMORY INSTRUCTIONS

| Accumulator and | | In | nme | | | ire | | 1 | nde | x | E | xter | nd | 1 | nhe | r | Boolean | (| Con | ditio | on (| Cod | es |
|-------------------|------|----|-----|---------------|----|-----|---|----|-----|---|----|------|----|----|-----|---|-----------------|----|-----|-------|------|-----|--------|
| Memory Operations | MNE | Op | ~ | # | Op | ~ | # | Op | ~ | # | Op | ~ | # | Op | ~ | # | Expression | Н | T | N | Z | V | C |
| Add Acmitrs | ABA | | | Г | П | | | | | | | | | 1B | 2 | 1 | A + B A | II | | 1 | T | T | T |
| Add B to X | ABX | | | | | | | | | | | | | 3A | 3 | 1 | 00 B + X - X | | | | | | |
| Add with Carry | ADCA | 89 | 2 | 2 | 99 | 3 | 2 | Α9 | 4 | 2 | B9 | 4 | 3 | | | Г | A + M + C - A | T | | 1 | 1 | T | 11 |
| | ADCB | C9 | 2 | 2 | D9 | 3 | 2 | E9 | 4 | 2 | F9 | 4 | 3 | | | Γ | B + M + C B | T | | | 1 | TT | П |
| Add | ADDA | 8B | 2 | 2 | 9B | 3 | 2 | AB | 4 | 2 | BB | 4 | 3 | | | Г | A + M -A | П | | 1 | T | TT | П |
| | ADDB | СВ | 2 | 2 | DB | 3 | 2 | EB | 4 | 2 | FB | 4 | 3 | | | Γ | B + M → A | T | | 1 | 1 | 1 | T |
| Add Double | ADDD | C3 | 4 | 3 | D3 | 5 | 2 | E3 | 6 | 2 | F3 | 6 | 3 | | | Г | D + M M + 1 -D | | | | 1 | T | 1 |
| And | ANDA | 84 | 2 | 2 | 94 | 3 | 2 | A4 | 4 | 2 | B4 | 4 | 3 | | | Г | A·M A | | | T | П | R | |
| | ANDB | C4 | 2 | 2 | D4 | 3 | 2 | E4 | 4 | 2 | F4 | 4 | 3 | | | Г | B · M → B | | | 1 | 1 | R | |
| Shift Left, | ASL | | T | Г | | | Г | 68 | 6 | 2 | 78 | 6 | 3 | | | Γ | ← | | | П | 11 | T | TT |
| Arithmetic | ASLA | | | | | | | | | | | | | 48 | 2 | 1 | © ← ∰₩₩₩ | | | 1 | 1 | П | П |
| | ASLB | | | $\overline{}$ | | | _ | | | | | | | 58 | 2 | 1 | b7 b0 | | | Π | | | \Box |

— Continued —

TABLE 10 — ACCUMULATOR AND MEMORY INSTRUCTIONS (CONTINUED)

| Accumulator and | 1 | In | nme | ā | Δ | irec | t | ŀ | rdex | | Ē | ten | ٩ | 1 | nhei | | Boolean | C | on | diti | or | C | ode | 98 |
|------------------------|--------------|--|----------|----------|--|----------|----------|--------|----------|---|--|---------------|----------|----------|----------|----------|---|---|----|--------------|--------|--------------|-----|----------------|
| Memory Operations | MNE | Op | ~ | # | Op | ~ | # | Op | ~ | # | Op | ` | # | Op | | # | Expression | Н | ī | Tr | V | Z | V | C |
| Shift Left Dbl | ASLD | | | | | | | | | | | | | 05 | 3 | 1 | | • | • | \mathbf{D} | Ι | I | | |
| Shift Right, | ASR | | | | | | | 67 | 6 | 2 | 77 | 6 | 3 | | | | ¬ → - | • | • | T | П | 1 | | |
| Arithmetic | ASRA | | Г | | | | | | | | | | | 47 | 2 | 1 | 0-(11111111- | • | • | T | π | 1 | 1 | 1 |
| | ASRB | | | | | | | | | | | | | 57 | 2 | 1 | b7 b0 | • | • | T | П | T | | |
| Bit Test | BITA | 85 | 2 | 2 | 95 | 3 | 2 | Α5 | 4 | 2 | В5 | 4 | 3 | | | | A · M | • | • | T | П | 1 | R | |
| | BITB | C5 | 2 | 2 | D5 | 3 | 2 | E5 | 4 | 2 | F5 | 4 | 3 | | | | B · M | • | • | T | П | 1 | R | • |
| Compare Acmitrs | CBA | | | | | | | | | П | | | | 11 | 2 | 1 | A - B | • | • | 1 | Т | 1 | 1 | |
| Clear | CLR | | | | | | | 6F | 6 | 2 | 7F | 6 | 3 | | | | 00 - M | • | • | | | s | R | R |
| | CLRA | | | | | | | | | П | | | | 4F | 2 | 1 | 00 - A | • | • | F | | s | R | |
| | CLRB | | | | | | | | | | | | | 5F | 2 | 1 | 00 - B | • | • | TF | | s | R | |
| Compare | CMPA | 81 | 2 | 2 | 91 | 3 | 2 | A1 | 4 | 2 | В1 | 4 | 3 | | | | A - M | • | • | | iT | 1 | 1 | 1 |
| • | СМРВ | | | | D1 | 3 | 2 | E1 | 4 | 2 | F1 | 4 | 3 | | | | B - M | • | • | Ħ | \Box | + | İ | 11 |
| 1's Complement | сом | | | | _ | Ť | | 63 | 6 | 2 | 73 | 6 | 3 | | | | M - M | • | • | H | 1 | + | R | ts |
| , c complement | COMA | 1 | | | | | | | | Н | | - | | 43 | 2 | 1 | Ā → A | • | • | | H | + | R | |
| | COMB | 1 | 1 | | | _ | | | _ | Н | \vdash | $\overline{}$ | | 53 | | | B B | • | • | - | H | + | R | |
| Decimal Adj, A | DAA | - | 1 | H | <u> </u> | | | | <u> </u> | Н | \vdash | | | 19 | 2 | | Adj binary sum to BCD | | • | - | H | + | 1 | 1 % |
| | DEC | ├ | | - | | - | H | 6A | 6 | 2 | 7A | 6 | 3 | -13 | - | | M - 1 -M | - | - | +4 | H | + | H | - |
| Decrement | | ├ | ╁ | - | | _ | - | 0A | - | - | /^ | 0 | ٦ | 44 | - | 1 | | - | _ | ++ | H | ÷ | H | ٠ |
| | DECA | | \vdash | Н | ├ | <u> </u> | \vdash | | - | H | - | - | - | 4A | 2 | 1 | A - 1 - A | • | • | 41 | # | ÷ | H | ٠ |
| - OD | DECB | 100 | 1- | - | 00 | - | 1 | 4.0 | - | 1 | 200 | | 1 | 5A | 4 | Ц. | B - 1 B | • | • | + | 4 | ļ | 1 | |
| Exclusive OR | EORA | 88 | 2 | | 98 | 3 | 2 | A8 | 4 | 2 | B8 | 4 | 3 | | | Щ | A ⊕ M - A | • | • | | 4 | Ļ | R | |
| | EORB | C8 | 2 | 2 | D8 | 3 | 2 | E8 | 4 | 2 | F8 | 4 | S | | | Ш | B ⊕ M - B | • | • | _ | 4 | 1 | R | - |
| Increment | INC | L | <u> </u> | | L | | L | 6C | 6 | 2 | 7C | 6 | 3 | لـبــا | L_ | Ш | M + 1 - M | • | • | - | 4 | 1 | П | • |
| | INCA | | <u></u> | | L | | | | | | | | | 4C | 2 | 1 | A + 1 - A | • | • | Ŀ | Ц | 1 | L | |
| | INCB | 1_ | L | | <u></u> | | | | _ | | | | | 5C | 2 | 1 | B + 1 → B | • | • | L | Ц | 1 | Ц | • |
| Load Acmitrs | LDAA | 86 | 2 | 2 | 96 | 3 | 2 | A6 | 4 | 2 | В6 | 4 | 3 | | | | M - A | • | • | | Π | | R | • |
| | LDAB | C6 | 2 | 2 | D6 | 3 | 2 | E6 | 4 | 2 | F6 | 4 | 3 | | | | M →B | • | • | П | π | T | R | |
| Load Double | LDD | cc | 3 | 3 | DC | 4 | 2 | EC | 5 | 2 | FC | 5 | 3 | | | | M M + 1 D | • | • | T | П | 1 | R | |
| Logical Shift, | LSL | 1 | | | | | | 68 | 6 | 2 | 78 | 6 | 3 | | | | | • | • | T | it | Ť | 1 | Ħ |
| Left | LSLA | 1 | | | | | | - | _ | | | | _ | 48 | 2 | 1 | a | • | • | † | H | + | 1 | 11 |
| | LSLB | 1 | | | - | _ | | | 1 | | | | | 58 | 2 | 1 | a⊷iiiiiiiiiiiiii ↔ | • | • | _ | + | ÷ | Ť | 11 |
| | LSLD | | \vdash | \vdash | <u> </u> | | - | | \vdash | - | \vdash | | \vdash | 05 | 3 | 1 | 07 00 | • | • | - | H | + | 1 | Н |
| Shift Right, | LSR | \vdash | + | - | | _ | \vdash | 64 | 6 | 2 | 74 | 6 | 3 | -00 | ۲ | ÷ | | • | • | _ | + | + | + | ++ |
| _ | LSRA | - | ┢ | \vdash | | | Н | 04 | 1- | - | / | - | ٦ | 44 | 2 | - | ∘→□□□□□→□ | _ | | _ | | + | H | 11 |
| Logical | | ├- | - | Н | <u> </u> | | - | | | - | _ | | H | | | 1 | b7 b0 | • | • | - | 1 | Ļ | H | H |
| | LSRB | ├ | - | Ш | <u> </u> | <u> </u> | - | | <u> </u> | H | _ | _ | <u> </u> | 54 | 2 | 1 | | • | • | | | ∔ | H | H |
| | LSRD | └ | | Щ | <u> </u> | _ | _ | | <u> </u> | L | | _ | _ | 04 | 3 | 1 | | • | | | 1 | i | | ļ. |
| Multiply | MUL | | | | L | | | | | | | | | 3D | 10 | 1 | A X B - D | • | • | | | • | | Li |
| 2's Complement | NEG | | | | L | | L | 60 | 6 | 2 | 70 | 6 | 3 | | | | 00 - M M | • | • | | \Box | 1 | | Li |
| (Negate) | NEGA | | | | | | | | | | | | | 40 | 2 | | 00 - A - A | • | | Ш | Ш | 1 | Li | L |
| | NEGB | | | | | | | | | | | | | 50 | 2 | 1 | 00 - B B | • | • | | ŧΙ | 1 | | П |
| No Operation | NOP | Ι | | | | | | | | | | | | 01 | 2 | 1 | PC + 1 - PC | • | • | T | • | • | | |
| Inclusive OR | ORAA | 8A | 2 | 2 | 9A | 3 | 2 | AA | 4 | 2 | ВА | 4 | 3 | | | | A + M A | • | • | 17 | ſΤ | 1 | R | |
| | ORAB | CA | 2 | | DA | 3 | 2 | EA | 4 | 2 | FA | 4 | 3 | | | | B + M → B | • | • | \Box | IT | Ī | R | • |
| Push Data | PSHA | | 1 | | | | Н | | | Н | 1 | | H | 36 | 3 | 1 | A -Stack | • | • | | | • | • | - |
| | PSHB | | \vdash | | | | Н | | _ | | | $\overline{}$ | Н | 37 | 3 | | B - Stack | • | è | | | ÷ | ě | ۱ŏ |
| Pull Data | PULA | | \vdash | Н | | _ | Н | | - | Н | - | - | \vdash | 32 | 4 | | Stack - A | • | • | _ | _ | ÷ | • | |
| run Data | PULB | - | \vdash | Н | | _ | Н | _ | - | Н | - | | Н | 33 | 4 | | Stack - B | - | • | - | + | ÷ | - | |
| Data ta Lafe | ROL | - | - | Н | | | Н | 69 | 6 | 2 | 79 | 6 | 3 | 33 | - | 4 | Stack - B | • | ÷ | | 7 | | ۲ | ۲ |
| Rotate Left | | - | \vdash | Н | | | Н | 09 | 0 | _ | /9 | 0 | P | 40 | _ | - | a- 111111111111111111111111111111111111 | | | _ | 4 | 1 | H | ++ |
| | ROLA | <u> </u> | | | L., | | Ш | | | _ | | | Щ | 49 | 2 | 1 | | • | • | - | Ц | Ļ | H | ш |
| | ROLB | <u> </u> | L_ | _ | | | Ш | | | _ | | | Ш | 59 | 2 | 1 | | • | • | | 4 | 1 | Ц | H |
| Rotate Right | ROR | | | | | | Ц | 66 | 6 | 2 | 76 | 6 | 3 | | | | | • | • | | Ц | 1 | Ц | 11 |
| | RORA | | | | | | | | | | | | | 46 | 2 | 1 | 0+CTTTTTTT-0 | • | • | Ш | Ш | 1 | | 1 |
| | RORB | | | | | | | | | | | | | 56 | 2 | 1 | b7 b0 | • | • | Γ | П | 1 | 1 | П |
| Subtract Acmitr | SBA | | | | | | | | | | | | | 10 | 2 | 1 | A - B A | • | • | П | П | 1 | П | П |
| Subtract with | SBCA | 82 | 2 | 2 | 92 | 3 | 2 | A2 | 4 | 2 | B2 | 4 | 3 | | | \dashv | A - M - C - A | • | • | | T | T | 7 | 11 |
| Carry | SBCB | C2 | | | D2 | 3 | | E2 | 4 | 2 | F2 | 4 | 3 | | | \dashv | B · M C → B | • | • | | 1 | T | 7 | 17 |
| Store Acmitrs | STAA | <u> </u> | Ħ | Н | 97 | 3 | | A7 | 4 | | B7 | 4 | 3 | | \vdash | \dashv | A -M | • | • | + | + | + | R | 1 6 |
| Otore Monney | STAB | _ | Н | - | D7 | 3 | 2 | E7 | 4 | 2 | F7 | 4 | 3 | - | Η- | Н | B →M | • | ÷ | +1 | 1 | t | R | |
| | STD | ├ | Н | \vdash | DD | 4 | | ED | 5 | | FD | 5 | 3 | | - | Н | D - M M + 1 | • | • | | + | + | R | |
| 6.1. | | 00 | 1 | | 90 | | _ | | | | | | _ | | \vdash | Н | | _ | Ī | - | + | ÷ | _ | 1-7 |
| Subtract | SUBA | 80 | 2 | 2 | | 3 | | A0 | 4 | 2 | B0 | 4 | 3 | | \vdash | Н | A - M A | • | • | | + | 1 | H | ! |
| | SUBB | co | 2 | | DO | 3 | 2 | EO | 4 | 2 | F0 | 4 | 3 | | _ | Ц | B - M → B | • | • | | 4 | 1 | H | H |
| Subtract Double | SUBD | 83 | 4 | 3 | 93 | 5 | 2 | А3 | 6 | 2 | В3 | 6 | 3 | | Ш | Ш | D - M M + 1 - D | • | • | - | 1 | 1 | Ш | Ш |
| Transfer Acmitr | TAB | | | | | | \Box | I | | | | | | 16 | | | A B | • | • | Ц | П | \mathbf{f} | R | |
| | TBA | | | | | | | 1 | | | | | | 17 | 2 | 1 | B →A | • | • | | J | T | R | |
| | | | _ | _ | | | | 6D | 6 | 2 | 7D | 6 | 3 | | | | M - 00 | • | • | П | T | I | R | |
| Test, Zero or | TST | | | | | | | | | | | | | | | | | | | | | | | |
| Test, Zero or Minus | | | Н | \dashv | | | \Box | \neg | | | - | | | 4D | 2 | 1 | | | • | T | T | | R | R |
| Test, Zero or Minus | TSTA TSTB | | H | | | _ | \Box | | | | | | H | 4D 5D | 2 | | A - 00 B - 00 | • | • | Ħ | F | 1 | R | |

The Condition Code Register notes are listed after Table 10

TABLE 11 - JUMP AND BRANCH INSTRUCTIONS

| | 1 | Τ | | | | | | Γ | | | | | | Π | | | | C | onc | 1. (| od | e R | eg. |
|--------------------------|----------|----|-----|---|----|------|---|----|-----|---|----|-----|---|----|------|-----|---------------------------|---|-----|------|----|-----|-----|
| | | _ | ire | - | - | elat | _ | _ | nde | | _ | xtn | d | In | here | ent | | 5 | 4 | 3 | 2 | 1 | 0 |
| Operations | Mnemonic | OP | ~ | # | OP | ' ~ | # | OP | ~ | # | OΡ | ~ | # | OF | - | # | Branch Test | Н | ı | N | Z | V | С |
| Branch Always | BRA | | Γ | Г | 20 | 3 | 2 | | | | | Г | Г | | Τ | | None | • | • | • | • | • | • |
| Branch Never | BRN | | Γ | | 21 | 3 | 2 | | Γ | | | Г | Г | | Г | | None | • | • | • | • | | • |
| Branch If Carry Clear | BCC | Π | Γ | Γ | 24 | 3 | 2 | Π | Γ | | | | | Г | T | | C = 0 | • | | | • | • | • |
| Branch If Carry Set | BCS | Г | Γ | Г | 25 | 3 | 2 | Π | Γ | | | Г | | | Τ | | C = 1 | • | • | • | • | • | • |
| Branch If = Zero | BEQ | | Г | Γ | 27 | 3 | 2 | | Г | Г | | Γ | | | T | | Z = 1 | • | • | • | • | • | • |
| Branch If ≥ Zero | BGE | | Γ | | 2C | 3 | 2 | | Г | Г | | | Ī | Г | T | Г | N⊕V = 0 | • | • | • | • | | • |
| Branch If > Zero | BGT | Г | Г | Γ | 2E | 3 | 2 | Г | Γ | | | | | | Т | Т | Z + (N ⊕ V) = 0 | • | • | • | • | • | • |
| Branch If Higher | BHI | | Γ | Γ | 22 | 3 | 2 | Г | Γ | | | Г | Г | | T | T | C + Z = 0 | • | • | • | • | • | • |
| Branch If Higher or Same | BHS | | Γ | Г | 24 | 3 | 2 | | Γ | | | Г | | | T | Γ | C = 0 | • | | • | • | • | • |
| Branch If ≤ Zero | BLE | | | | 2F | 3 | 2 | | | | | | | | | T | Z + (N ⊕ V) = 1 | • | • | • | • | • | • |
| Branch If Carry Set | BLO | | | | 25 | 3 | 2 | | | | | Г | Γ | | Т | П | C = 1 | • | • | • | • | • | • |
| Branch If Lower Or Same | BLS | | | | 23 | 1 | 2 | | | | | Γ | | | Τ | | C + Z = 1 | • | • | • | • | • | • |
| Branch If < Zero | BLT | | | | 2D | 3 | 2 | | | | | Г | | | T | | N⊕V = 1 | • | • | • | • | • | • |
| Branch If Minus | BMI | | | | 2B | 3 | 2 | Г | | | | | | Г | T | П | N = 1 | • | • | • | • | • | • |
| Branch If Not Equal Zero | BNE | | | | 26 | 3 | 2 | Г | | | | Г | Г | Γ | T | | Z = 0 | • | • | • | • | • | • |
| Branch If Overflow Clear | BVC | | Γ | Г | 28 | 3 | 2 | | | | | | Γ | | Γ | | V = 0 | • | • | • | • | • | • |
| Branch If Overflow Set | BVS | | Γ | | 29 | 3 | 2 | | | | | Г | | Г | | | V = 1 | • | • | • | • | • | • |
| Branch If Plus | BPL | | Γ | | 2A | 3 | 2 | | | | | | | | Π | | N = 0 | • | • | • | • | • | • |
| Branch To Subroutine | BSR | | | | 8D | 6 | 2 | | | | | | | | | |) See Special | • | • | • | | • | • |
| Jump | JMP | Π | Γ | Г | | Γ | Π | 6E | 3 | 2 | 7E | 3 | 3 | | Ī | | Operations - | • | • | • | • | • | • |
| Jump To Subroutine | JSR | 9D | 5 | 2 | Π | T | Π | AD | 6 | 2 | BD | 6 | 3 | Г | T | П | Figure 26 | • | • | • | • | • | • |
| No Operation | NOP | | Г | Γ | П | Т | Γ | Г | Γ | | | Г | Г | 01 | 2 | 1 | | • | • | • | • | • | • |
| Return From Interrupt | RTI | | Γ | Г | | T | Γ | | Г | | | Γ | Г | 3В | 10 | 1 | \ | 1 | T | 1 | 1 | 1 | 1 |
| Return From Subroutine | RTS | | Γ | Γ | | T | T | | Г | | | | Γ | 39 | 5 | 1 | See Special | • | • | • | • | • | • |
| Software Interrupt | SWI | Π | Γ | Γ | Г | Τ | Γ | Π | Γ | | | Γ | | 3F | 12 | 1 | Operations - Figure 26 | • | s | • | • | • | • |
| Wait For Interrupt | WAI | | T | Γ | | Τ | Γ | | Г | | | | Г | 3E | 9 | 1 | 7 | • | • | • | • | • | • |

TABLE 12 — CONDITION CODE REGISTER MANIPULATION INSTRUCTIONS

| | | | | | | (| one | 1 C | ode | Re | g |
|----------------------|----------|----|---|---|-------------------|----|-----|-----|-----|----|---|
| | Inhere | nt | | | | 5 | 4 | 3 | 2 | 1 | 0 |
| Operations | Mnemonic | OP | ~ | # | Boolean Operation | Н | Ti | N | z | V | С |
| Clear Carry | CLC | 0C | 2 | 1 | 0 - C | • | • | • | • | • | R |
| Clear Interrupt Mask | CLI | 0E | 2 | 1 | 0 +1 | • | R | • | • | • | • |
| Clear Overflow | CLV | 0A | 2 | 1 | 0 - V | • | • | • | • | R | • |
| Set Carry | SEC | OD | 2 | 1 | 1 - C | • | • | • | • | • | s |
| Set Interrupt Mask | SEI | 0F | 2 | 1 | 1 -1 | • | s | • | • | • | • |
| Set Overflow | SEV | ОВ | 2 | 1 | 1 - V | • | • | • | • | s | • |
| Accumulator A - CCR | TAP | 06 | 2 | 1 | A - CCR | 11 | T | T | 1 | T | T |
| CCR -Accumulator A | TPA | 07 | 2 | 1 | CCR -A | • | • | • | • | • | • |

LEGEND

- OPOperation Code (Hexadecimal)
- ~ Number of MPU Cycles

MSP Contents of memory location pointed to by Stack Pointer

- # Number of Program Bytes + Arithmetic Plus
- Arithmetic Minus
- Boolean AND
- X Arithmetic Multiply
- Boolean Exclusive OR
- M Complement of M
- Transfer Into
- O Bit = Zero 00 Byte = Zero
- + Boolean Inclusive OR

CONDITION CODE SYMBOLS

- H Half-carry from bit 3
- I Interrupt mask N Negative (sign bit)
- Z Zero (byte) V Overflow, 2's complement
- C Carry/Borrow from MSB
- R Reset Always
- S Set Always
- Affected
- Affectea
 Not Affected

TABLE 13 - INSTRUCTION EXECUTION TIMES IN E-CYCLES

| | | ADE | PESSI | NG MOI | DE | |
|--|---|------------------|---------------|-----------------------|-----------------------|---|
| | Immediate | Direct | Extended | Indexed | Inherent | Relative |
| ABA ABX ADC ADD ADDD AND ASL | 2 2 4 2 | 3 3 5 3 | • 4 4 6 4 6 6 | 4 4 6 4 6 | 2 3 • • • • 2 3 | • |
| ASLD ASR BCC BCS BEQ BGE BGT | • | | 6 | 6 | 2 | • 3 3 3 3 3 3 |
| BHI BHS BIT BLE BLO BLS BLT | 2 | 3 | 4 | 4 | • | 3 3 3 3 3 3 3 3 3 3 3 3 3 3 3 3 3 3 3 |
| BMI BNE BPL BRA BRN BSR BVC | • | • | • | • | • | 3 3 3 3 3 6 |
| BVS CBA CLC CLI CLR CLV CMP | • | • | 6 | 6 | 2 2 2 2 2 | 3 |
| COM CPX DAA DEC DES DEX EOR INC | 2 4 • • • • • • • • • • • • • • • • • • | 3 | 6 6 6 4 6 6 | 6 6 6 4 6 | 2 2 3 3 • • 3 | • |

| | | ADD | RESSIN | IG MO | DE | |
|--|------------------|----------------------------|----------------------------|----------------------------|--------------------------------------|---------------|
| | Immediate | Direct | Extended | Indexed | Inherent | Relative |
| JMP JSR LDA LDD LDS LDX LSL | 2 3 3 3 | 5 3 4 4 | 3 6 4 5 5 5 | 3 6 4 5 5 | 3 | • |
| LSLD LSR LSRD MUL NEG NOP | • | • | 6 6 | 6 6 | 2 3 2 3 10 2 2 | • • • • • |
| ORA PSH PSHX PUL PULX ROL ROR | 2 | 3 | • • • 6 6 | • • • 6 6 | 2 2 3 4 4 5 2 2 | • • • • • • |
| RTI RTS SBA SBC SEC SEI SEV | 2 | 3 | 4 | 4 | 5 2 • 2 2 | • |
| STA STD STS STX SUB SUBD SWI | 2 4 | 3 4 4 4 3 5 | 4 5 5 5 4 6 | 4 5 5 5 4 6 | 2 | • |
| TAB TAP TBA TPA TST TSX TXS WAI | • | • | 6 | 6 | 2 2 2 2 2 3 3 9 | • • • • • • • |

SUMMARY OF CYCLE-BY-CYCLE OPERATION

Table 14 provides a detailed description of the information present on the Address Bus, Data Bus, and the Read/Write (R/\overline{W}) line during each cycle of each instruction

The information is useful in comparing actual with expected results during debug of both software and hardware as the program is executed. The information is categorized in groups according to addressing mode and number of cycles

per instruction. In general, instructions with the same addressing mode and number of cycles execute in the same manner. Exceptions are indicated in the table.

Note that during MPU reads of internal locations, the resultant value will not appear on the external Data Bus except in Mode 0 "High order" byte refers to the most significant byte of a 16-bit value

TABLE 14 - CYCLE-BY-CYCLE OPERATION

| Address Mode & Instructions | Cycles | Cycle # | Address Bus | R/W Line | Data Bus |
|---|--------|-----------------------|--|-----------------------|--|
| IMMEDIATE | | | | | |
| ADC EOR ADD LDA AND ORA BIT SBC | 2 | 1 2 | Op Code Address Op Code Address + 1 | 1 1 | Op Code Operand Data |
| CMP SUB LDS LDX LDD | 3 | 1 2 3 | Op Code Address Op Code Address + 1 Op Code Address + 2 | 1 1 1 | Op Code Operand Data (High Order Byte) Operand Data (Low Order Byte) |
| CPX SUBD ADDD | 4 | 1 2 3 4 | Op Code Address Op Code Address + 1 Op Code Address + 2 Address Bus FFFF | 1 1 1 1 | Op Code Operand Data (High Order Byte) Operand Data (Low Order Byte) Low Byte of Restart Vector |
| DIRECT | | | | | |
| ADC EOR ADD LDA AND ORA BIT SBC CMP SUB | 3 | 1 2 3 | Op Code Address Op Code Address + 1 Address of Operand | 1 1 1 | Op Code Address of Operand Operand Data |
| STA | 3 | 1 2 3 | Op Code Address Op Code Address + 1 Destination Address | 1 1 0 | Op Code Destination Address Data from Accumulator |
| LDS LDX LDD | 4 | 1 2 3 4 | Op Code Address Op Code Address + 1 Address of Operand Operand Address + 1 | 1 1 1 | Op Code Address of Operand Operand Data (High Order Byte) Operand Data (Low Order Byte) |
| STS STX STD | 4 | 1 2 3 4 | Op Code Address Op Code Address + 1 Address of Operand Address of Operand + 1 | 1 1 0 0 | Op Code Address of Operand Register Data (High Order Byte) Register Data (Low Order Byte) |
| CPX SUBD ADDD | 5 | 1 2 3 4 5 | Op Code Address Op Code Address + 1 Operand Address Operand Address + 1 Address Bus FFFF | 1 1 1 1 | Op Code Address of Operand Operand Data (High Order Byte) Operand Data (Low Order Byte) Low Byte of Restart Vector |
| JSR . | 5 | 1 2 3 4 5 | Op Code Address Op Code Address + 1 Subroutine Address Stack Pointer Stack Pointer + 1 | 1 1 1 0 0 | Op Code Irrelevant Data First Subroutine Op Code Return Address (Low Order Byte) Return Address (High Order Byte) |

- Continued -

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TABLE 14 - CYCLE-BY-CYCLE OPERATION (CONTINUED)

| Address Mode & Instructions | Cycles | Cycle # | Address Bus | R/W Line | Data Bus |
|--------------------------------|--------|------------|---|---------------|--|
| EXTENDED | | | | | |
| JMP | 3 | 1 | Op Code Address | 1 1 | Op Code |
| | 1 1 | 2 | Op Code Address + 1 | 1 | Jump Address (High Order Byte) |
| | | 3 | Op Code Address + 2 | 1 | Jump Address (Low Order Byte) |
| ADC EOR | 4 | 1 | Op Code Address | 1 | Op Code |
| ADD LDA | 1 | 2 | Op Code Address + 1 | 1 | Address of Operand |
| AND ORA | | 3 | Op Code Address + 2 | 1 | Address of Operand |
| | | | | 1 | (Low Order Byte) |
| BIT SBC CMP SUB | | 4 | Address of Operand | 1 | Operand Data |
| STA | 4 | 1 | Op Code Address | 1 | Op Code |
| | 1 | 2 | Op Code Address + 1 | 1 | Destination Address |
| | 1 1 | | | | (High Order Byte) |
| | 1 1 | 3 | Op Code Address + 2 | 1 | Destination Address |
| | 1 1 | | | 1 | (Low Order Byte) |
| | 1 1 | 4 | Operand Destination Address | 0 | Data from Accumulator |
| LDS | 5 | 1 | Op Code Address | 1 | Op Code |
| LDX | 1 | 2 | Op Code Address + 1 | 1 | Address of Operand |
| | 1 1 | | | 1 | (High Order Byte) |
| LDD | 1 1 | 3 | Op Code Address + 2 | 1 | Address of Operand |
| | 1 i | | 1 . | 1 | (Low Order Byte) |
| | 1 1 | 4 | Address of Operand | 1 | Operand Data (High Order Byte) |
| | | 5 | Address of Operand + 1 | 1 | Operand Data (Low Order Byte) |
| STS | 5 | 1 | Op Code Address | 1 | Op Code |
| STX | | 2 | Op Code Address + 1 | 1 | Address of Operand |
| | 1 1 | _ | 1 | | (High Order Byte) |
| STD | 1 1 | 3 | Op Code Address + 2 | 1 | Address of Operand |
| | 1 1 | 4 | Address of Occasion | | (Low Order Byte) |
| | 1 1 | 4 5 | Address of Operand Address of Operand + 1 | 0 | Operand Data (High Order Byte) |
| | | | | 0 | Operand Data (Low Order Byte) |
| ASL LSR | 6 | 1 2 | Op Code Address | 1 | Op Code |
| ASR NEG | 1 1 | 2 | Op Code Address + 1 | 1 | Address of Operand |
| CLR ROL | 1 1 | 3 | Op Code Address + 2 | 1 | (High Order Byte) |
| CLN HOL | 1 1 | 3 | Op code Address 1 2 | ' | Address of Operand (Low Order Byte) |
| COM ROR | 1 1 | 4 | Address of Operand | 1 | Current Operand Data |
| DEC TST | 1 1 | 5 | Address Bus FFFF | l i | Low Byte of Restart Vector |
| INC | | 6 | Address of Operand | o | New Operand Data |
| CPX | 1 6 | 1 | Op Code Address | $\frac{1}{1}$ | Op Code |
| SUBD | | 2 | Op Code Address + 1 | l i | Operand Address |
| 3322 | 1 1 | | | 1 | (High Order Byte) |
| ADDD | 1 1 | 3 | Op code Address + 2 | 1 | Operand Address |
| | 1 | | | | (Low Order Byte) |
| | | 4 | Operand Address | 1 | Operand Data (High Order Byte) |
| | | 5 | Operand Address + 1 | 1 | Operand Data (Low Order Byte) |
| | | 6 | Address Bus FFFF | 1 | Low Byte of Restart Vector |
| JSR | 6 | 1 | Op Code Address | 1 | Op Code |
| | 1 | 2 | Op Code Address + 1 | 1 | Address of Subroutine |
| | 1 | | | | (High Order Byte) |
| | | 3 | Op Code Address + 2 | 1 | Address of Subroutine |
| | 1 | | | | (Low Order Byte) |
| | | 4 | Subroutine Starting Address | 1 | Op Code of Next Instruction |
| | | 5 | Stack Pointer | 0 | Return Address |
| | | | | | (Low Order Byte) |
| | | 6 | Stack Pointer - 1 | 0 | Return Address |
| | | | | | (High Order Byte) |

- Continued -

TABLE 14 - CYCLE-BY-CYCLE OPERATION (CONTINUED)

| Address Mode & Instructions | Cycles | Cycle # | Address Bus | R/W Line | Data Bus |
|-----------------------------|--------|------------|--------------------------------|-------------|----------------------------------|
| INDEXED | | | | | |
| JMP | 3 | 1 | Op Code Address | 1 | Op Code |
| | 1 1 | 2 | Op Code Address + 1 | 1 | Offset |
| | | 33 | Address Bus FFFF | 1 | Low Byte of Restart Vector |
| ADC EOR | 4 | 1 | Op Code Address | 1 | Op Code |
| ADD LDA | 1 1 | 2 | Op Code Address + 1 | 1 | Offset |
| AND ORA | 1 1 | 3 | Address Bus FFFF | 1 | Low Byte of Restart Vector |
| BIT SBC | | 4 | Index Register Plus Offset | 1 | Operand Data |
| CMP SUB | 1 1 | | | Į. | |
| STA | 4 | 1 | Op Code Address | 1 | Op Code |
| | 1 1 | 2 | Op Code Address + 1 | 1 | Offset |
| | | 3 | Address Bus FFFF | 1 | Low Byte of Restart Vector |
| | | 4 | Index Register Plus Offset | 0 | Operand Data |
| LDS | 5 | 1 | Op Code Address | 1 | Op Code |
| LDX | 1 1 | 2 | Op Code Address + 1 | 1 | Offset |
| LDD | 1 | 3 | Address Bus FFFF | 1 | Low Byte of Restart Vector |
| | 1 | 4 | Index Register Plus Offset | 1 | Operand Data (High Order Byte) |
| | | 5 | Index Register Plus Offset + 1 | 1 | Operand Data (Low Order Byte) |
| STS | 5 | 1 | Op Code Address | 1 | Op Code |
| STX | 1 | 2 | Op Code Address + 1 | 1 | Offset |
| STD | ļ) | 3 | Address Bus FFFF | 1 | Low Byte of Restart Vector |
| | 1 | 4 | Index Register Plus Offset | 0 | Operand Data (High Order Byte) |
| | 1 | 5 | Index Register Plus Offset + 1 | 0 | Operand Data (Low Order Byte) |
| ASL LSR | 6 | 1 | Op Code Address | 1 | Op Code |
| ASR NEG | | 2 | Op Code Address + 1 | 1 | Offset |
| CLR ROL | | 3 | Address Bus FFFF | 1 | Low Byte of Restart Vector |
| COM ROR | 1 1 | 4 | Index Register Plus Offset | 1 | Current Operand Data |
| DEC TST (1) | | 5 | Address Bus FFFF | 1 | Low Byte of Restart Vector |
| INC | 1 1 | 6 | Index Register Plus Offset | 0 | New Operand Data |
| CPX | 6 | 1 | Op Code Address | 1 | Op Code |
| SUBD | 1 1 | 2 | Op Code Address + 1 | 1 | Offset |
| ADDD | 1 1 | 3 | Address Bus FFFF | 1 | Low Byte of Restart Vector |
| | 1 | 4 | Index Register + Offset | 1 | Operand Data (High Order Byte) |
| | 1 1 | 5 | Index Register + Offset + 1 | 1 | Operand Data (Low Order Byte) |
| | | 6 | Address Bus FFFF | | Low Byte of Restart Vector |
| JSR | 6 | 1 | Op Code Address | 1 | Op Code |
| | | 2 | Op Code Address + 1 | 1 | Offset |
| | 1 1 | 3 | Address Bus FFFF | 1 | Low Byte of Restart Vector |
| | | 4 | Index Register + Offset | 1 | First Subroutine Op Code |
| | | 5 | Stack Pointer | 0 | Return Address (Low Order Byte) |
| | | 6 | Stack Pointer - 1 | 0 | Return Address (High Order Byte) |

- Continued -

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TABLE 14 - CYCLE-BY-CYCLE OPERATION (CONTINUED)

| Address Mode & Instructions | Cycles | Cycle # | Address Bus | R/W Line | Data Bus |
|---|--------|-----------------------|--|------------------|--|
| INHERENT | | <u> </u> | | | |
| ABA DAA SEC ASL DEC SEI ASR INC SEV CBA LSR TAB CLC NEG TAP CLI NOP TBA CLR ROL TPA CLV ROR TST COM SBA | 2 | 1 2 | Op Code Address Op Code Address +1 | 1 1 | Op Code Op Code of Next Instruction |
| ABX | 3 | 1 2 3 | Op Code Address Op Code Address +1 Address Bus FFFF | 1 1 1 | Op Code Irrelevent Data Low Byte of Restart Vector |
| ASLD LSRD | 3 | 1 2 3 | Op Code Address Op Code Address +1 Address Bus FFFF | 1 1 1 | Op Code Irrelevant Data Low Byte of Restart Vector |
| DES INS | 3 | 1 2 3 | Op Code Address Op Code Address +1 Previous Register Contents | 1 1 1 | Op Code Op Code of Next Instruction Irrelevant Data |
| INX DEX | 3 | 1 2 3 | Op Code Address Op Code Address +1 Address Bus FFFF | 1 1 1 | Op Code Op Code of Next Instruction Low Byte of Restart Vector |
| PSHA PSHB | 3 | 1 2 3 | Op Code Address Op Code Address +1 Stack Pointer | 1 1 0 | Op Code Op Code of Next Instruction Accumulator Data |
| TSX | 3 | 1 2 3 | Op Code Address Op Code Address +1 Stack Pointer | 1 1 1 | Op Code Op Code of Next Instruction Irrelevant Data |
| TXS | 3 | 1 2 3 | Op Code Address Op Code Address +1 Address Bus FFFF | 1 1 1 | Op Code Op Code of Next Instruction Low Byte of Restart Vector |
| PULA PULB | 4 | 1 2 3 4 | Op Code Address Op Code Address +1 Stack Pointer Stack Pointer +1 | 1 1 1 | Op Code Op Code of Next Instruction Irrelevant Data Operand Data from Stack |
| PSHX | 4 | 1 2 3 4 | Op Code Address Op Code Address +1 Stack Pointer Stack Pointer -1 | 1 1 0 0 | Op Code Irrelevant Data Index Register (Low Order Byte) Index Register (High Order Byte) |
| PULX | 5 | 1 2 3 4 5 | Op Code Address Op Code Address +1 Stack Pointer Stack Pointer +1 Stack Pointer +2 | 1 1 1 1 | Op Code Irrelevant Data Irrelevant Data Index Register (High Order Byte) Index Register (Low Order Byte) |

— Continued —

TABLE 14 — CYCLE-BY-CYCLE OPERATION (CONTINUED)

| Address Mode & | Τ | Cycle | T | R/W | |
|----------------|--------|-------|---------------------------|-------|----------------------------------|
| Instructions | Cycles | # | Address Bus | Line | Data Bus |
| INHERENT | | | | | |
| RTS | 5 | 1 | Op Code Address | 1 | Op Code |
| | l | 2 | Op Code Address +1 | 1 | Irrelevant Data |
| | | 3 | Stack Pointer | 1 1 | Irrelevant Data |
| | | 4 | Stack Pointer +1 | 1 1 | Address of Next Instruction |
| | | 1 | | | (High Order Byte) |
| | 1 | 5 | Stack Pointer +2 | 1 1 | Address of Next Instruction |
| | | | | | (Low Order Byte) |
| WAI | 9 | 1 | Op Code Address | 1 | Op Code |
| **** | 1 | 2 | Op Code Address +1 | 1 1 | Op Code of Next Instruction |
| | i | 3 | Stack Pointer | 0 | Return Address (Low Order Byte) |
| | 1 | 4 | Stack Pointer -1 | 101 | Return Address |
| | | | | | (High Order Byte) |
| | | 5 | Stack Pointer -2 | 0 | Index Register (Low Order Byte) |
| | | 6 | Stack Pointer -3 | 0 | Index Register (High Order Byte) |
| | | 7 | Stack Pointer -4 | 1 0 1 | Contents of Accumulator A |
| | Į. | 8 | Stack Pointer -5 | 0 | Contents of Accumulator B |
| | | 9 | Stack Pointer -6 | 0 | Contents of Cond Code Register |
| MUL | 10 | 1 | Op Code Address | 1 | Op Code |
| WOL | 10 | 2 | Op Code Address +1 | | Irrelevant Data |
| | | 3 | Address Bus FFFF | i | Low Byte of Restart Vector |
| | | 4 | Address Bus FFFF | | Low Byte of Restart Vector |
| | | 5 | Address Bus FFFF | | Low Byte of Restart Vector |
| | į. | 6 | Address Bus FFFF | 1 ; 1 | Low Byte of Restart Vector |
| | | 7 | Address Bus FFFF | | Low Byte of Restart Vector |
| | 1 | 8 | Address Bus FFFF | 1 1 | Low Byte of Restart Vector |
| | | 9 | Address Bus FFFF | 1 1 | Low Byte of Restart Vector |
| | 1 | 10 | Address Bus FFFF | 1 1 | Low Byte of Restart Vector |
| | | L | | | |
| RTI | 10 | 1 | Op Code Address | 1 1 | Op Code |
| | | 2 | Op Code Address +1 | 1 1 | Irrelevant Data |
| | | 3 | Stack Pointer | 1 1 | Irrelevant Data |
| | l | 4 | Stack Pointer +1 | 1 1 | Contents of Cond Code Reg |
| | 1 | _ | | | from Stack |
| | | 5 | Stack Pointer +2 | 1 1 | Contents of Accumulator B |
| | Ī | | | | from Stack |
| | 1 | 6 | Stack Pointer +3 | 1 1 | Contents of Accumulator A |
| | | l _ | | | from Stack |
| | 1 | 7 | Stack Pointer +4 | 1 1 | Index Register from Stack |
| | 1 | | | | (High Order Byte) |
| | | 8 | Stack Pointer +5 | 1 | Index Register from Stack |
| | | | | | (Low Order Byte) |
| | | 9 | Stack Pointer +6 | 1 1 | Next Instruction Address from |
| | ì | | | | Stack (High Order Byte) |
| | Į. | 10 | Stack Pointer +7 | 1 1 | Next Instruction Address from |
| d 1/ | | | | | Stack (Low Order Byte) |
| SWI | 12 | 1 | Op Code Address | 1 | Op Code |
| | | 2 | Op Code Address +1 | 1 1 | Irrelevant Data |
| | 1 | 3 | Stack Pointer | 0 | Return Address (Low Order Byte) |
| | 1 | 4 | Stack Pointer -1 | 0 | Return Address |
| | 1 | | | | (High Order Byte) |
| | l | 5 | Stack Pointer -2 | 0 | Index Register (Low Order Byte) |
| | | 6 | Stack Pointer -3 | 0 | Index Register (High Order Byte) |
| | 1 | 7 | Stack Pointer -4 | 0 | Contents of Accumulator A |
| | 1 | 8 | Stack Pointer -5 | 0 | Contents of Accumulator B |
| | 1 | 9 | Stack Pointer -6 | 0 | Contents of Cond Code Register |
| | 1 | 10 | Stack Pointer -7 | 1 1 | Irrelevant Data |
| | 1 | 11 | Vector Address FFFA (Hex) | 1 1 | Address of Subroutine |
| | l | l | 1 | | (High Order Byte) |
| | 1 | 12 | Vector Address FFFB (Hex) | 1 | Address of Subroutine |
| | 1 | l | I . | | (Low Order Byte) |

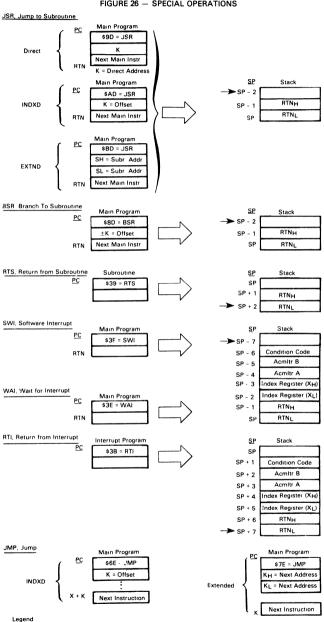
— Continued —

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TABLE 14 — CYCLE-BY-CYCLE OPERATION (CONCLUDED)

| Address Mode & Instructions | Cycles | Cycle # | Address Bus | R/W Line | Data Bus |
|-----------------------------|--------|------------|-----------------------------|-------------|--------------------------------|
| RELATIVE | | | | | |
| BCC BHT BNE BLO | 3 | 1 | Op Code Address | 1 | Op Code |
| BCS BLE BPL BHS | 1 | 2 | Op Code Address +1 | 1 1 | Branch Offset |
| BEQ BLS BRA BRN | 1 | 3 | Address Bus FFFF | 1 1 | Low Byte of Restart Vector |
| BGE BLT BVC | 1 | | | - | |
| BGT BMT BVS | 1 | | | 1 1 | |
| BSR | 6 | 1 | Op Code Address | 1 | Op Code |
| | 1 | 2 | Op Code Address +1 | 1 1 | Branch Offset |
| ì | | 3 | Address Bus FFFF | 1 1 | Low Byte of Restart Vector |
| | | 4 | Subroutine Starting Address |] 1] | Op Code of Next Instruction |
| i | | 5 | Stack Pointer | 1 0 1 | Return Address (Low Order Byt |
| i | | 6 | Stack Pointer -1 | 0 | Return Address (High Order Byt |

FIGURE 26 - SPECIAL OPERATIONS



Legend

RTN = Address of next instruction in Main Program to be executed upon return from subroutine RTNH = Most significant byte of Return Address RTNL = Least significant byte of Return Address

⁼⁼ Stack Pointer After Execution

K = 8-bit Unsigned Value

APPENDIX CUSTOM MC6801 ORDERING INFORMATION

A.0 CUSTOM MC6801 ORDERING INFORMATION

The custom MC6801 specifications may be transmitted to Motorola in any of the following media

- 1) PROM(s)
- 2) MDOS diskette

The specification should be formatted and packed, as indicated in the appropriate paragraph below, and mailed prepaid and insured with a cover letter (see Figure A-2) to

Motorola Inc 3501 Ed Bluestein Blvd Austin, Texas 78721

A copy of the cover letter should also be mailed separately

A.1 PROMs

MCM2708 and MCM2716 type PROMs, programmed with the custom program (positive logic sense for address and

data), may be submitted for pattern generation. The MC2708s must be clearly marked to indicate which PROM corresponds to which address space (\$X800-\$XFFF). See Figure A-1 for recommended marking procedure.

After the PROM(s) are marked, they should be placed in conductive IC carriers and securely packed. Do not use styrofoam





FIGURE A-1 XXX = Customer ID

A.2 DISKETTE (MDOS)

The start/end location should be written on the label EX-ORcisor format

FIGURE A-2

| CUSTOMER NAME | | |
|---|------------------------|-----|
| ADDRESS | | |
| STATE | CITY | ZIP |
| PHONE () | EXTENSION | |
| CONTACT MS/MR | | |
| CUSTOMER PART # | | |
| ROM START ADDRESS OPTION | TEMPERATURE RANGE | |
| □ \$C800 | □ 0° to 70°C | |
| □ \$D800 | | |
| □ \$E800 | | |
| □ \$F800 | | |
| ☐ A12 and A13 don't care | PACKAGE TYPE | |
| | □ Ceramic □ Plastic | |
| | Plastic | |
| | MARKING | |
| PATTERN MEDIA | ☐ Standard | |
| □ 2708 PROM | ☐ Special | |
| □ 2716 PROM | | |
| ☐ Diskette (MDOS) | | |
| (Note 1) | | |
| NOTE: (1) Other Media Require Prior Factory | Approval | |
| SIGNATURE | | |
| TITLE | | |

-MC6801L1 — LILBug[™] Monitor -

An MC6801 may be purchased without specifying the ROM pattern This standard part is labeled as MC6801L1 and contains a 2K monitor in the ROM. The monitor, LILbug, may be used to evaluate and debug a program under development. Details and a source listing are specified in the "LILbug Manual".

IMPORTANT NOTICE

Devices made with mask #T5P may generate multiple framing error flags in response to unframed data. These devices will eventually synchronize correctly after a framing error, but valid, framed data following an unframed data byte may generate false framing error flags.



MICROPROCESSOR WITH CLOCK AND OPTIONAL RAM

The MC6802 is a monolithic 8-bit microprocessor that contains all the registers and accumulators of the present MC6800 plus an internal clock oscillator and driver on the same chip. In addition, the MC6802 has 128 bytes of on-board RAM located at hex addresses \$0000 to \$007F. The first 32 bytes of RAM, at hex addresses \$0000 to \$001F, may be retained in a low power mode by utilizing VCC standby, thus, facilitating memory retention during a power-down situation.

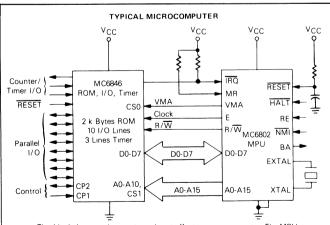
The MC6802 is completely software compatible with the MC6800 as well as the entire M6800 family of parts. Hence, the MC6802 is expandable to 64K words.

The MC6802NS is identical to the MC6802 without standby RAM feature. The MC6808 is identical to the MC6802 without on-board RAM.

- On-Chip Clock Circuit
- 128 × 8 Bit On-Chip RAM
- 32 Bytes of RAM are Retainable
- Software-Compatible with the MC6800
- Expandable to 64K Words
- Standard TTL-Compatible Inputs and Outputs
- 8-Bit Word Size
- 16-Bit Memory Addressing
- Interrupt Capability

PART NUMBER DESIGNATION BY SPEED

| MC6802 (1 0 MHz) | MC6808 (1 0 MHz) | MC6802NS (1 0 MHz) |
|----------------------|----------------------|-----------------------|
| MC68A02 (1 5 MHz) | MC68A08 (1 5 MHz) | |
| MC68B02 (2 0 MHz) | MC68B08 (2 0 MHz) | |



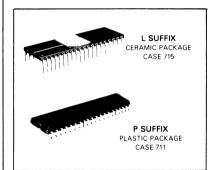
This block diagram shows a typical cost effective microcomputer. The MPU is the center of the microcoputer system and is shown in a minimum system interfacing with a ROM combination chip. It is not intended that this system be limited to this function but that it be expandable with other parts in the M6800 Microcomputer family.

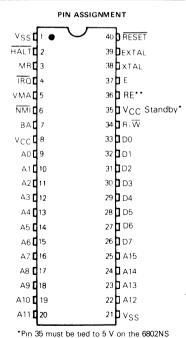
MC6802 MC6808 MC6802NS

MOS

(N-CHANNEL, SILICON-GATE, DEPLETION LOAD)

MICROPROCESSOR
WITH CLOCK AND OPTIONAL RAM





*Pin 35 must be tied to 5 V on the 6802NS **Pin 36 must be tied to ground for the 6808

MAXIMUM RATINGS

| Rating | Symbol | Value | Unit |
|-----------------------------|------------------|-------------|------|
| Supply Voltage | Vcc | -03 to +70 | ٧ |
| Input Voltage | V _{in} | -03 to +70 | ٧ |
| Operating Temperature Range | TA | 0 to +70 | °C |
| Storage Temperature Range | T _{stg} | -55 to +150 | °C |

THERMAL CHARACTERISTICS

| Characteristic | Symbol | Value | Unit |
|--|---------------|-------|-------|
| Average Thermal Resistance (Junction to Ambient) | | | |
| Plastic | ۵., | 100 | °C/W |
| Ceramic | θ_{JA} | 50 | C/ VV |

This input contains circuitry to protect the inputs against damage due to high static voltages or electric fields, however, it is advised that normal precautions be taken to avoid application of any voltage higher than maximum rated voltages to this high-impedance circuit. Reliability of operation is enhanced if unused inputs are tied to an appropriate logic voltage level le g , either VSS or $V_{CC})$

POWER CONSIDERATIONS

The average chip-junction temperature, TJ, in °C can be obtained from

$$T_{J} = T_{A} + (P_{D} \bullet \theta_{JA})$$

Where

T_A ≡ Ambient Temperature, °C

 θ JA = Package Thermal Resistance, Junction-to-Ambient, °C/W

PD = PINT + PPORT

PINT≡ICC×VCC, Watts - Chip Internal Power

 $P_{PORT} = Port Power Dissipation, Watts - User Determined$

For most applications $PPORT \blacktriangleleft PINT$ and can be neglected PPORT may become significant if the device is configured to drive Darlington bases or sink LED loads

An approximate relationship between PD and TJ (if PPORT is neglected) is

$$P_D = K - (T_J + 273 ^{\circ}C)$$

(2)

Solving equations 1 and 2 for K gives

 $K = P_D \bullet (T_A + 273 \circ C) + \theta_{JA} \bullet P_D^2$

(3)

(1)

Where K is a constant pertaining to the particular part. K can be determined from equation 3 by measuring P_D (at equilibrium) for a known T_A . Using this value of K the values of P_D and T_J can be obtained by solving equations (1) and (2) iteratively for any value of T_A .

MC6802 • MC6808 • MC6802NS

OPERATING TEMPERATURE RANGE

| Device | Speed | Symbol | Value | Unit |
|---------------------------------------|-------------------------------------|--------|------------------------|------|
| MC6802P,L MC6802CP,CL | (1 0 MHz) (1 0 MHz) | TA | 0 to +70 -40 to +85 | °C |
| MC68A02P,L MC68A02CP,CL | (1 5 MHz) (1 5 MHz) | ТД | 0 to +70 -40 to +85 | °C |
| MC68B02P,L MC68B02CP,CL | (2 0 MHz) (2 0 MHz) | TA | 0 to +70 -40 to +85 | °C |
| MC6802NSP,L | (1 0 MHz) | TA | 0 to +70 | °C |
| MC6808P,L MC68A08P,L MC68B08P,L | (1 0 MHz) (1 5 MHz) (2 0 MHz) | TA | 0 to +70 | °C |

DC ELECTRICAL CHARACTERISTICS ($V_{CC} = 5.0 \text{ Vdc} \pm 5\%$, $V_{SS} = 0$, $T_A = 0$ to 70°C , unless otherwise noted)

| Characteristic | | Symbol | Mın | Тур | Max | Unit |
|--|---|-------------------------------------|---|-----------|---------------------|------|
| Input High Voltage | Logic, EXTAL, RESET | VIH | V _{SS} +20 V _{SS} +40 | - | V _{CC} | V |
| Input Low Voltage | Logic, EXTAL, RESET | VIL | V _{SS} -03 | - | V _{SS} +08 | ٧ |
| Input Leakage Current (V _{In} = 0 to 5 25 V, V _{CC} = max) | Logic | l _{in} | - | 10 | 25 | μΑ |
| Output High Voltage (ILoad = -205 µA, VCC = min) (ILoad = -145 µA, VCC = min) (ILoad = -100 µA, VCC = min) | D0-D7 A0-A15, R/ W , VMA, E BA | Vон | V _{SS} +24 V _{SS} +24 V _{SS} +24 | - | - - - | v |
| Output Low Voltage (I _{Load} = 1 6 mA, V _{CC} = min) | | VOL | _ | _ | Vss+04 | ٧ |
| Internal Power Dissipation (Measured at T _A = 0°C) | | PINT | - | 0 600 | 10 | W |
| V _{CC} Standby | Power Down Power Up | V _{SBB} V _{SB} | 4 0 4 75 | - | 5 25 5 25 | ٧ |
| Standby Current | | ISBB | | - | 8.0 | mΑ |
| Capacitance # $(V_{ID} = 0, T_A = 25$ °C, f = 1 0 MHz) | D0-D7 Logic Inputs, EXTAL | C _{in} | | 10 6 5 | 12 5 10 | рF |
| | A0-A15, R/\overline{W}, VMA | Cout | | | 12 | pF |

^{*}In power-down mode, maximum power dissipation is less than 42 $\ensuremath{\text{mW}}$

#Capacitances are periodically sampled rather than 100% tested

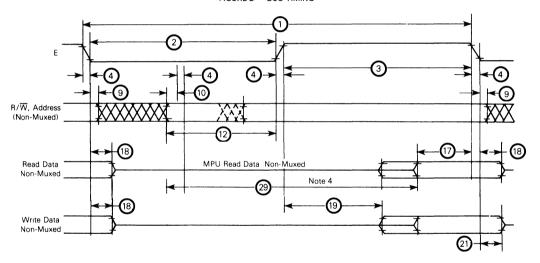
CONTROL TIMING ($V_{CC} = 5.0 \text{ V } \pm 5\%$, $V_{SS} = 0$, $T_A = T_L$ to T_H , unless otherwise noted)

| Characteristics | Symbol | MC6802NS, MC6808 | | MC68A02 MC68A08 | | MC68B02 MC68B08 | | Unit |
|--|------------------|---------------------|-----|--------------------|-----|--------------------|-----|------|
| | 1 | Min | Max | Min | Max | Mın | Max | |
| Frequency of Operation | fo | 01 | 10 | 0 1 | 15 | 01 | 20 | MH!z |
| Crystal Frequency | fXTAL | 10 | 40 | 10 | 60 | 10 | 80 | MHz |
| External Oscillator Frequency | 4xf _O | 04 | 40 | 0 4 | 60 | 04 | 80 | MHz |
| Crystal Oscillator Start Up Time | trc | 100 | - | 100 | | 100 | _ | ms |
| Processor Controls (HALT, MR, RE, RESET, IRQ NMI) | | | | | | | | |
| Processor Control Setup Time | [†] PCS | 200 | - | 140 | - | 110 | - | ns |
| Processor Control Rise and Fall Time (Does Not Apply to RESET) | tPCr, tPCf | - | 100 | - | 100 | - | 100 | ns |

BUS TIMING CHARACTERISTICS

| Ident. Number | Characteristic | Symbol | MC6802NS MC6802 MC6808 | | MC68A02 MC68A08 | | MC68B02 MC68B08 | | Unit |
|------------------|--|---------------------------------|------------------------------|----------|--------------------|------|--------------------|------|------|
| | | | Min | Max | Min | Max | Min | Max | |
| 1 | Cycle Time | tcyc | 10 | 10 | 0 667 | 10 | 05 | 10 | μS |
| 2 | Pulse Width, E Low | PWEL | 450 | 5000 | 280 | 5000 | 210 | 5000 | ns |
| 3 | Pulse Width, E High | PWEH | 450 | 9500 | 280 | 9700 | 220 | 9700 | ns |
| 4 | Clock Rise and Fall Time | t _r , t _f | - | 25 | - | 25 | _ | 20 | ns |
| 9 | Address Hold Time | ^t AH | 20 | - | 20 | - | 20 | _ | าร |
| 12 | Non-Muxed Address Valid Time to E (See Note 5) | tAV1 | 160 - | _ 270 | 100 - | - | 50 - | - | ns |
| 17 | Read Data Setup Time | †DSR | 100 | _ | 70 | - | 60 | - | ns |
| 18 | Read Data Hold Time | tDHR | 10 | _ | 10 | _ | 10 | | ns |
| 19 | Write Data Delay Time | tDDW | _ | 225 | _ | 170 | - | 160 | ns |
| 21 | Write Data Hold Time | tDHW | 30 | - | 20 | - | 20 | _ | ns |
| 29 | Usable Access Time (See Note 4) | tACC | 605 | - | 310 | _ | 235 | - | ns |
| | | | | | | | | | |

FIGURE 2 - BUS TIMING



NOTES

- 1 Voltage levels shown are $V_L \le 0.4 \text{ V}$, $V_H \ge 2.4 \text{ V}$, unless otherwise specified
- 2 Measurement points shown are 0 8 V and 2 0 V, unless otherwise noted
- 3 All electricals shown for the MC6802 apply to the MC6802NS and MC6808, unless otherwise noted
- 4 Usable access time is computed by 12+3+4-17
- 5 If programs are not executed from on-board RAM, TAV1 applies If programs are to be stored and executed from on-board RAM, TAV2 applies For normal data storage in the on-board RAM, this extended delay does not apply Programs cannot be executed from on-board RAM when using A and B parts (MC68A02, MC68A08, MC68B08). On-board RAM can be used for data storage with all parts.

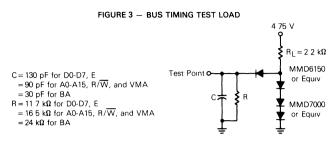


FIGURE 4 — TYPICAL DATA BUS OUTPUT DELAY versus CAPACITIVE LOADING

FIGURE 5 — TYPICAL READ/WRITE, VMA AND ADDRESS OUTPUT DELAY versus CAPACITIVE LOADING

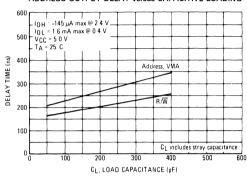
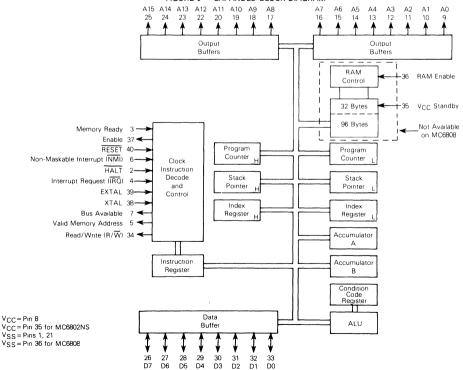


FIGURE 6 - EXPANDED BLOCK DIAGRAM



MPU REGISTERS

A general block diagram of the MC6802 is shown in Figure 6. As shown, the number and configuration of the registers are the same as for the MC6800. The 128 × 8-bit RAM* has been added to the basic MPU. The first 32 bytes can be retained during power-up and power-down conditions via the RE signal.

The MC6802NS is identical to the MC6802 except for the standby feature on the first 32 bytes of RAM. The standby feature does not exist on the MC6802NS and thus pin 35 must be tied to 5 V.

The MC6808 is identical to the MC6802 except for onboard RAM. Since the MC6808 does not have on-board RAM pin 36 must be tied to ground allowing the processor to utilize up to 64K bytes of external memory

The MPU has three 16-bit registers and three 8-bit registers available for use by the programmer (Figure 7)

PROGRAM COUNTER

The program counter is a two byte (16-bit) register that points to the current program address

STACK POINTER

The stack pointer is a two byte register that contains the address of the next available location in an external push-down/pop-up stack. This stack is normally a random access

read/write memory that may have any location (address) that is convenient. In those applications that require storage of information in the stack when power is lost, the stack must be non-volatile.

INDEX REGISTER

The index register is a two byte register that is used to store data or a 16-bit memory address for the indexed mode of memory addressing

ACCUMULATORS

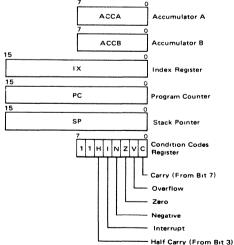
The MPU contains two 8-bit accumulators that are used to hold operands and results from an arithmetic logic unit (ALU)

CONDITION CODE REGISTER

The condition code register indicates the results of an Arithmetic Logic Unit operation: Negative (N), Zero (Z), Overflow (V), Carry from bit 7 (C), and Half Carry from bit 3 (H). These bits of the Condition Code Register are used as testable conditions for the conditional branch instructions. Bit 4 is the interrupt mask bit (I). The unused bits of the Condition Code Register (b6 and b7) are ones.

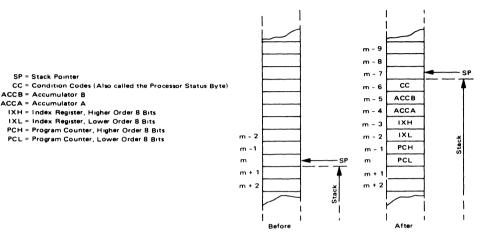
Figure 8 shows the order of saving the microprocessor status within the stack.

FIGURE 7 — PROGRAMMING MODEL OF THE MICROPROCESSING UNIT



^{*}If programs are not executed from on-board RAM, TAV1 applies. If programs are to be stored and executed from on-board RAM, TAV2 applies. For normal data storage in the on-board RAM, this extended delay does not apply Programs cannot be executed from on-board RAM when using A and B parts (MC68A02, MC68A08, MC68B02, and MC68B08) On-board RAM can be used for data storage with all parts.

FIGURE 8 - SAVING THE STATUS OF THE MICROPROCESSOR IN THE STACK



MPU SIGNAL DESCRIPTION

Proper operation of the MPU requires that certain control and timing signals be provided to accomplish specific functions and that other signal lines be monitored to determine the state of the processor These control and timing signal are similar to those of the MC6800 except that TSC, DBE, $\phi 1, \ \phi 2$ input, and two unused pins have been eliminated, and the following signal and timing lines have been added

RAM Enable (RE)
Crystal Connections EXTAL and XTAL

Memory Ready (MR)

VCC Standby

Enable ϕ 2 Output (E)

The following is a summary of the MPU signals

ADDRESS BUS (A0-A15)

Sixteen pins are used for the address bus. The outputs are capable of driving one standard TTL load and 90 pF. These lines do not have three-state capability.

DATA BUS (D0-D7)

Eight pins are used for the data bus. It is bidirectional, transferring data to and from the memory and peripheral devices. It also has three-state output buffers capable of driving one standard TTL load and 130 pF.

Data bus will be in the output mode when the internal RAM is accessed and RE will be high. This prohibits external data entering the MPU. It should be noted that the internal RAM is fully decoded from \$0000 to \$007F. External RAM at \$0000 to \$007F must be disabled when internal RAM is accessed.

HALT

When this input is in the low state, all activity in the machine will be halted. This input is level sensitive. In the $\overline{\rm HALT}$ mode, the machine will stop at the end of an instruc-

tion, bus available will be at a high state, valid memory address will be at a low state. The address bus will display the address of the next instruction

 $\overline{\mbox{HALT}}$ line must occur tpcs before the falling edge of E and the $\overline{\mbox{HALT}}$ line must go high for one clock cycle.

HALT should be tied high if not used. This is good engineering design practice in general and necessary to ensure proper operation of the part.

READ/WRITE (R/W)

This TTL-compatible output signals the peripherals and memory devices whether the MPU is in a read (high) or write (low) state. The normal standby state of this signal is read (high). When the processor is halted, it will be in the read state. This output is capable of driving one standard TTL load and 90 pF.

VALID MEMORY ADDRESS (VMA)

This output indicates to peripheral devices that there is a valid address on the address bus. In normal operation, this signal should be utilized for enabling peripheral interfaces such as the PIA and ACIA. This signal is not three-state. One standard TTL load and 90 pF may be directly driven by this active high signal.

BUS AVAILABLE (BA) — The bus available signal will normally be in the low state, when activated, it will go to the high state indicating that the microprocessor has stopped and that the address bus is available (but not in a three-state condition). This will occur if the HALT line is in the low state or the processor is in the WAIT state as a result of the execution of a WAIT instruction. At such time, all three-state output drivers will go to their off-state and other outputs to their normally inactive level. The processor is removed from the

WAIT state by the occurrence of a maskable (mask bit I = 0) or nonmaskable interrupt. This output is capable of driving one standard TTL load and 30 pF.

INTERRUPT REQUEST (IRQ)

A low level on this input requests that an interrupt sequence be generated within the machine. The processor will wait until it completes the current instruction that is being excuted before it recognizes the request. At that time, if the interrupt mask bit in the condition code register is not set, the machine will begin an interrupt sequence. The index register, program counter, accumulators, and condition code register are stored away on the stack. Next the MPU will respond to the interrupt request by setting the interrupt mask bit high so that no further interrupts may occur. At the end of the cycle, a 16-bit vectoring address which is located in memory locations \$FFF8 and \$FFF9 is loaded which causes the MPU to branch to an interrupt routine in memory.

The HALT line must be in the high state for interrupts to be serviced. Interrupts will be latched internally while HALT is low.

A nominal 3 $k\Omega$ pullup resistor to VCC should be used for wire-OR and optimum control of interrupts \overline{IRQ} may be tied directly to VCC if not used

RESET

This input is used to reset and start the MPU from a power-down condition, resulting from a power failure or an initial start-up of the processor. When this line is low, the MPU is inactive and the information in the registers will be lost. If a high level is detected on the input, this will signal the MPU to begin the restart sequence. This will start execu-

tion of a routine to initialize the processor from its reset condition. All the higher order address lines will be forced higher the restart, the last two (\$FFFE, \$FFFF) locations in memory will be used to load the program that is addressed by the program counter. During the restart routine, the interrupt mask bit is set and must be reset before the MPU can be interrupted by $\overline{\text{IRO}}$. Power-up and reset timing and power-down sequences are shown in Figures 9 and 10, respectively

RESET, when brought low, must be held low at least three clock cycles This allows adequate time to respond internally to the reset This is independent of the $t_{\Gamma C}$ power-up reset that is required.

When RESET is released it *must* go through the low-tohigh threshold without bouncing, oscillating, or otherwise causing an erroneous reset (less than three clock cycles) This may cause improper MPU operation until the next valid reset

NON-MASKABLE INTERRUPT (NMI)

A low-going edge on this input requests that a non-maskable interrupt sequence be generated within the processor. As with the interrupt request signal, the processor will complete the current instruction that is being executed before it recognizes the \overline{NMl} signal. The interrupt mask bit in the condition code register has no effect on \overline{NMl}

The index register, program counter, accumulators, and condition code registers are stored away on the stack. At the end of the cycle, a 16-bit vectoring address which is located in memory locations \$FFFC and \$FFFD is loaded causing the MPU to branch to an interrupt service routine in memory.

A nominal 3 k Ω pullup resistor to VCC should be used for wire-OR and optimum control of interrupts \overline{NMI} may be tied

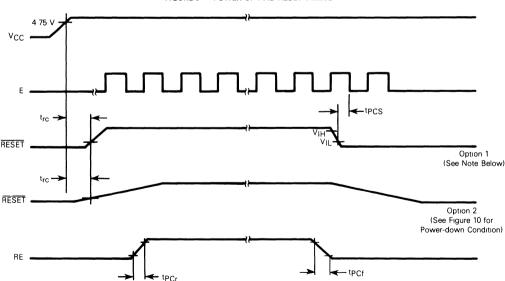


FIGURE 9 - POWER-UP AND RESET TIMING

NOTE If option 1 is chosen, RESET and RE pins can be tied together

directly to VCC if not used

Inputs IRQ and NMI are hardware interrupt lines that are sampled when E is high and will start the interrupt routine on a low E following the completion of an instruction

Figure 11 is a flowchart describing the major decision paths and interrupt vectors of the microprocessor Table 1 gives the memory map for interrupt vectors

TABLE 1 - MEMORY MAP FOR INTERRUPT VECTORS

| Vec | tor | Description | | |
|--------|--------|------------------------|--|--|
| MS | LS | Description | | |
| \$FFFE | \$FFFF | Restart | | |
| \$FFFC | \$FFFD | Non-Maskable Interrupt | | |
| \$FFFA | \$FFFB | Software Interrupt | | |
| \$FFF8 | \$FFF9 | Interrupt Request | | |

Vcc Ε t_{CPS} tPCf → RE

FIGURE 10 - POWER-DOWN SEQUENCE

FIGURE 11 - MPU FLOWCHART

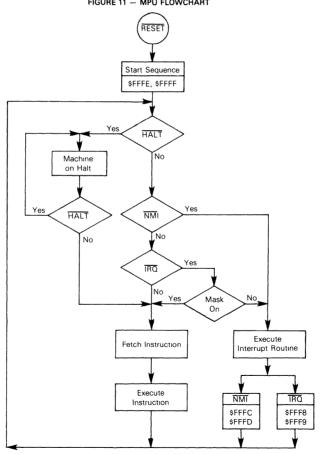
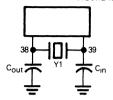
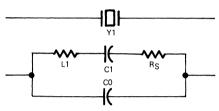


FIGURE 12 - CRYSTAL SPECIFICATIONS



| Y1 | Cin | Cout |
|----------|-------|-------|
| 3 58 MHz | 27 pF | 27 pF |
| 4 MHz | 27 pF | 27 pF |
| 6 MHz | 20 pF | 20 pF |
| 8 MHz | 18 pF | 18 pF |

Crystal Loading



Nominal Crystal Parameters*

| | 3.58 MHz | 4.0 MHz | 6.0 MHz | 8.0 MHz |
|----|----------|----------|--------------|--------------|
| RS | 60 Ω | 50 Ω | 30-50 Ω | 20-40 Ω |
| CO | 35 pF | 6 5 pF | 4-6 pF | 4-6 pF |
| C1 | 0 015 pF | 0 025 pF | 0 01-0 02 pF | 0 01-0 02 pF |
| Q | >40K | >30K | > 20K | > 20K |

^{*}These are representative AT-cut parallel resonance crystal parameters only Crystals of other types of cuts may also be used

Figure 13 - SUGGESTED PC BOARD LAYOUT

Example of Board Design Using the Crystal Oscillator

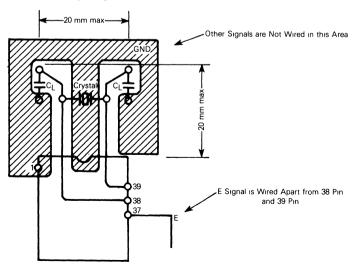


FIGURE 14 - MEMORY READY SYNCHRONIZATION

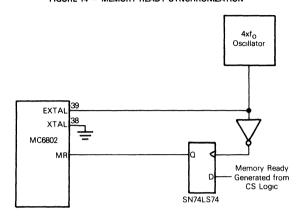
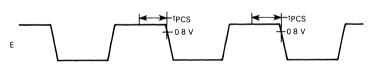


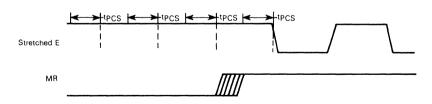
FIGURE 15 - MR NEGATIVE SETUP TIME REQUIREMENT

E Clock Stretch



The E clock will be stretched at end of E high of the cycle during which MR negative meets the tpcs setup time. The tpcs setup time is referenced to the fall of E. If the tpcs setup time is not met, E will be stretched at the end of the next E-high ½ cycle. E will be stretched in integral multiples of ½ cycles.

Resuming E Clocking



The E clock will resume normal operation at the end of the ½ cycle during which MR assertion meets the tpcs setup time. The tpcs setup time is referenced to transitions of E were it not stretched. If tpcs setup time is not met, E will fall at the second possible transition time after MR is asserted. There is no direct means of determining when the tpcs references occur, unless the synchronizing circuit of Figure 14 is used.

RAM ENABLE (RE - MC6802 + MC6802NS ONLY)

A TTL-compatible RAM enable input controls the on-chip RAM of the MC6802. When placed in the high state, the on-chip memory is enabled to respond to the MPU controls. In the low state, RAM is disabled. This pin may also be utilized to disable reading and writing the on-chip RAM during a power-down situation. RAM Enable must be low three cycles before VCC goes below 4.75 V during power-down RAM enable must be tied low on the MC6808. RE should be tied to the correct high or low state if not used.

EXTAL AND XTAL

These inputs are used for the internal oscillator that may be crystal controlled. These connections are for a parallel resonant fundamental crystal (see Figure 12). (AT-cut.) A divide-by-four circuit has been added so a 4 MHz crystal may be used in lieu of a 1 MHz crystal for a more cost-effective system. An example of the crystal circuit layout is shown in Figure 13. Pin 39 may be driven externally by a TTL input signal four times the required E clock frequency. Pin 38 is to be grounded.

An RC network is not directly usable as a frequency source on pins 38 and 39. An RC network type TTL or CMOS oscillator will work well as long as the TTL or CMOS output drives the on-chip oscillator.

LC networks are not recommended to be used in place of the crystal

If an external clock is used, it may not be halted for more than $tpW_{\varphi L}$. The MC6802, MC6808 and MC6802NS are dynamic parts except for the internal RAM, and require the external clock to retain information.

MEMORY READY (MR)

MR is a TTL-compatible input signal controlling the stretching of E. Use of MR requires synchronization with the $4xf_{\rm O}$ signal, as shown in Figure 14. When MR is high, E will be in normal operation. When MR is low, E will be stretched integral numbers of half periods, thus allowing interface to slow memories. Memory Ready timing is shown in Figure 15.

MR should be tied high (connected directly to VCC) if not used. This is necessary to ensure proper operation of the part. A maximum stretch is $t_{\rm CVC}$

ENABLE (E)

This pin supplies the clock for the MPU and the rest of the system. This is a single-phase, TTL-compatible clock. This clock may be conditioned by a memory read signal. This is equivalent to $\phi 2$ on the MC6800. This output is capable of driving one standard TTL load and 130 pF

V_{CC} STANDBY (MC6802 ONLY)

This pin supplies the dc voltage to the first 32 bytes of RAM as well as the RAM Enable (RE) control logic. Thus, retention of data in this portion of the RAM on a power-up, power-down, or standby condition is guaranteed. Maximum current drain at VSB maximum is ISBB. For the MC6802NS this pin must be connected to VCC.

MPU INSTRUCTION SET

The instruction set has 72 different instructions. Included are binary and decimal arithmetic, logical, shift, rotate, load, store, conditional or unconditional branch, interrupt and stack manipulation instructions (Tables 2 through 6). The instruction set is the same as that for the MC6800.

MPU ADDRESSING MODES

There are seven address modes that can be used by a programmer, with the addressing mode a function of both the type of instruction and the coding within the instruction. A summary of the addressing modes for a particular instruction can be found in Table 7 along with the associated instruction execution time that is given in machine cycles. With a bus frequency of 1 MHz, these times would be microseconds.

ACCUMULATOR (ACCX) ADDRESSING

In accumulator only addressing, either accumulator A or accumulator B is specified. These are one-byte instructions $% \left(A_{1}\right) =A_{1}^{2}$

IMMEDIATE ADDRESSING

In immediate addressing, the operand is contained in the second byte of the instruction except LDS and LDX which have the operand in the second and third bytes of the instruction. The MPU addresses this location when it fetches the immediate instruction for execution. These are two-or three-byte instructions.

DIRECT ADDRESSING

In direct addressing, the address of the operand is contained in the second byte of the instruction. Direct addressing allows the user to directly address the lowest 256 bytes in the machine, i.e., locations zero through 255. Enhanced execution times are achieved by storing data in these locations. In most configurations, it should be a random-access memory. These are two-byte instructions.

EXTENDED ADDRESSING

In extended addressing, the address contained in the second byte of the instruction is used as the higher eight bits of the address of the operand. The third byte of the instruction is used as the lower eight bits of the address for the operand. This is an absolute address in memory. These are three-byte instructions.

INDEXED ADDRESSING

In indexed addressing, the address contained in the second byte of the instruction is added to the index register's lowest eight bits in the MPU. The carry is then added to the higher order eight bits of the index register. This result is then used to address memory. The modified address is held in a temporary address register so there is no change to the index register. These are two-byte instructions.

MC6802 • MC6808 • MC6802NS

IMPLIED ADDRESSING

In the implied addressing mode, the instruction gives the address (i.e., stack pointer, index register, etc.) These are one-byte instructions

RELATIVE ADDRESSING

In relative addressing, the address contained in the second

byte of the instruction is added to the program counter's lowest eight bits plus two The carry or borrow is then added to the high eight bits. This allows the user to address data within a range of -125 to +129 bytes of the present instruction These are two-byte instructions

TABLE 2 - MICROPROCESSOR INSTRUCTION SET - ALPHABETIC SEQUENCE

| ABA | Add Accumulators | CLR | Clear | PUL | Pull Data |
|---|--|---|--|--|--|
| ADC ADD AND ASL | Add with Carry Add Logical And Arithmetic Shift Left | CLV CMP COM CPX | Clear Overflow Compare Complement Compare Index Register | ROL ROR RTI RTS | Rotate Left Rotate Right Return from Interrupt Return from Subroutine |
| BCC BCS BEQ BGE | Branch if Carry Clear Branch if Carry Set Branch if Equal to Zero Branch if Greater or Equal Zero | DEC DES DEX | Decrement Stack Pointer Decrement Index Register | SBA SBC SEC SEI | Subtract Accumulators Subtract with Carry Set Carry Set Interrupt Mask |
| BGT BHI BIT BLE BLS | Branch if Greater than Zero Branch if Higher Bit Test Branch if Less or Equal Branch if Lower or Same | INC INS INX | Increment Increment Stack Pointer Increment Index Register | STA STS STX SUB | Store Accumulator Store Stack Register Store Index Register Subtract |
| BMI | Branch if Minus | JSR | Jump to Subroutine | TAB | Transfer Accumulators |
| BPL BRA | Branch if Not Equal to Zero Branch if Plus Branch Always Branch to Subroutine | LDS LDX | Load Stack Pointer Load Index Register | TBA TPA TST | Transfer Accumulators to Condition Code Heg Transfer Accumulators Transfer Condition Code Reg to Accumulator Test |
| BVC BVS | Branch if Overflow Clear Branch if Overflow Set | NEG NOP | Negate No Operation | TSX TXS | Transfer Stack Pointer to Index Register Transfer Index Register to Stack Pointer |
| CBA CLC CLI | Compare Accumulators Clear Carry Clear Interrupt Mask | ORA PSH | Inclusive OR Accumulator Push Data | WAI | Wait for Interrupt |
| ASR BCC BCS BEQ BGE BHI BIT BLE BLS BLT BME BPL BRA BVC BVS CCBA CCLC | Arithmetic Shift Right Branch if Carry Clear Branch if Carry Set Branch if Equal to Zero Branch if Greater or Equal Zero Branch if Greater than Zero Branch if Higher Bit Test Branch if Less or Equal Branch if Less or Equal Branch if Lower or Same Branch if Lower or Same Branch if Minus Branch if Minus Branch if Not Equal to Zero Branch if Not Equal to Zero Branch Always Branch to Subroutine Branch if Overflow Clear Branch if Overflow Set Compare Accumulators Clear Carry | DAA DEC DES DEX EOR INC INS INX JSR LDA LDS LDS LSR NEG NOP | Decimal Adjust Decrement Decrement Stack Pointer Decrement Index Register Exclusive OR Increment Increment Stack Pointer Increment Index Register Jump Jump to Subroutine Load Accumulator Load Stack Pointer Load Index Register Logical Shift Right Negate No Operation Inclusive OR Accumulator | SBA SBC SEC SEI SEV STA STS STX SUB SWI TAB TAP TBA TPA TST TSX | Subtract Accumulators Subtract with Carry Set Carry Set Interrupt Mask Set Overflow Store Accumulator Store Stack Register Store Index Register Subtract Software Interrupt Transfer Accumulators Transfer Accumulators Transfer Accumulators Transfer Accumulators Transfer Condition Code Reg to Accum Test Transfer Stack Pointer to Index Regist |

TABLE 3 - ACCUMULATOR AND MEMORY INSTRUCTIONS

| | ADDRESSING MODES | | | | | | | | BOOLEAN/ARITHMETIC OPERATION | _ | _ | - | - | | | | | | | | | |
|-----------------------------------|------------------|----------|-----|----------|----------|------|---|----------|------------------------------|----|----------|-----|---|------|------|-----|---------------------------------------|-------|-----|-----|------|-----------|
| | | | MME | <u> </u> | D | IREC | T | - 11 | NDE) | Κ | E) | XTN | D | IM | PLIE | D | (All register labels | | | | | 1 |
| OPERATIONS | MNEMONIC | OP | ~ | = | OP | ` | = | OP | ` | = | OP | ` | = | OP | ` | = | refer to contents) | Н | 1 | N . | Z | ٧ |
| Add | ADDA | 38 | 2 | 2 | 9B | 3 | 2 | AB | 5 | 2 | 88 | 4 | 3 | | | | A + M · A | 1:1 | • | : | : | 1 |
| | ADDB | СВ | 2 | 2 | DB | 3 | 2 | ЕΒ | 5 | 2 | FB | 4 | 3 | | | | B + M - B | | | | | 1 |
| Add Acmitrs | ABA | ı | | | | | | | | | | | | 18 | 2 | 1 | A + B · A | 1 . 1 | - 1 | ٠. | | 1 |
| Add with Carry | ADCA | 89 | 2 | 2 | 99 | 3 | 2 | A9 | 5 | 2 | B9 | 4 | 3 | | | | A·M·C A | 1 . (| - 1 | ٠, | | 1 |
| And | ADCB ANDA | C9 84 | 2 | 2 | D9 94 | 3 | 2 | E9 A4 | 5 | 2 | F9 B4 | 4 | 3 | | | | B+M+C B | 1 . 1 | - 1 | ٠. | | 1 |
| Allu | ANDB | C4 | 2 | 2 | D4 | 3 | 2 | E4 | 5 | 2 | F4 | 4 | 3 | | | | A M · A B M B | 1 - 1 | - 1 | ٠, | | R |
| Bit Test | BITA | 85 | 2 | 2 | 95 | 3 | 2 | A5 | 5 | 2 | 85 | 4 | 3 | | | | AM | | - 1 | | | R |
| J. 1031 | BITB | C5 | 2 | 2 | D5 | 3 | 2 | E5 | 5 | 2 | F5 | 4 | 3 | | | | ВМ | 1 1 | - 1 | ٠, | | R |
| Clear | CLR | 1 | | - | | - | - | 6F | 7 | 2 | 7 F | 6 | 3 | | | | 00 · M | | | R : | | R |
| | CLRA | 1 | | | 1 | | | | | | ĺ | | | 4F | 2 | -1 | 00 A | • | | | | R |
| | CLRB | l | | | | | | | | | | | | 5F | 2 | 1 | 00 в | • | • | | | R |
| Compare | CMPA | 81 | 2 | 2 | 91 | 3 | 2 | A1 | 5 | 2 | B1 | 4 | 3 | | | 1 | A M | | • | 1 | 1 | 1 |
| | CMPB | C1 | 2 | 2 | 01 | 3 | 2 | E1 | 5 | 2 | F1 | 4 | 3 | | | - 1 | ВМ | • | • | ! | : | 1 |
| Compare Acmitrs | CBA | } | | | 1 | | | | | | 1 | | | 11 | 2 | -1 | A B | 1 - 1 | - 1 | | | 1 |
| Complement, 1's | COM | l | | | | | | 63 | 7 | 2 | 73 | 6 | 3 | | | | M M | 1 - 1 | - 1 | | | R |
| | COMA | } | | | 1 | | | 1 | | | 1 | | | 43 | 2 | 1 | Ā · A | | - 1 | | | R |
| | COMB | 1 | | | | | | | | | | | | 53 | 2 | 1 | B - B | | - 1 | | | R |
| Complement, 2 s | NEG | 1 | | | 1 | | | 60 | 7 | 2 | 70 | 6 | 3 | | _ | . | 00 M M | | | | | 9 |
| (Negate) | NEGA | 1 | | | 1 | | | 1 | | | l | | | 40 | 2 | ! | 00 A · A | | | | : (| 1 |
| D | NEGB | 1 | | | | | | } | | | 1 | | | 50 | 2 | 1 | 00 8 8 | | | : I | | D |
| Decimal Adjust A | DAA | i | | | | | | | | | | | | 19 | 2 | 1 | Converts Binary Add of BCD Characters | • | • | : | : | : (|
| 0 | 0.50 | l | | | 1 | | | ١., | , | 2 | | | , | | | - 1 | into BCD Format | 1.1 | - | . | J. | إ |
| Decrement | DEC | 1 | | | | | | 6A | 7 | 2 | 7A | 6 | 3 | ١ | | . 1 | M 1 M | | | | ŀ | 9 |
| | DECA | Į | | | | | | l | | | | | | 4A | 2 | 1 | A 1 A | | | | : [9 | <u>ə</u> |
| Exclusive OR | EORA | 88 | 2 | - | 98 | • | | | | | 1 | | | 5A | 2 | ' | B 1 B | | | | | a |
| Excinsive OH | EORB | C8 | 2 | 2 | D8 | 3 | 2 | A8 | 5 | 2 | B8 | 4 | 3 | | | ı | A⊕M · A | 1 - 1 | - 1 | | | R |
| Increment | INC | 1 60 | 2 | 2 | 00 | 3 | 2 | 6C | 7 | 2 | F8 7C | 6 | 3 | | | | B⊕M B M+1 • M | | • | | | R S |
| mcrement | INCA | i | | | | | | 66 | ′ | ۷, | / (| ь | , | 4 C | 2 | , | | | • | ٠. | | |
| | INCA | 1 | | |) | | | | | | | | | 5C | 2 | 1 | A+1 4 B+1 B | 1 . 1 | | ٠, | : [| 3 |
| Load Acmitr | LDAA | 86 | 2 | 2 | 96 | 3 | 2 | A6 | 5 | 2 | В6 | 4 | 3 | 36 | 2 | ' | M A | 1 . 1 | | | | 5) R |
| Long Fiching | LDAB | C6 | 2 | 2 | D6 | 3 | 2 | €6 | 5 | 2 | +6 | 4 | 3 | | | | M B | 1 - 1 | | : | | R |
| Or Inclusive | ORAA | BA | 2 | 2 | 9A | 3 | 2 | AA | 5 | 2 | ВА | 4 | 3 | | | 1 | A+M A | 1 1 | | | - 1 | R |
| OT IIICIOSIVE | ORAB | CA | 2 | 2 | DA | 3 | 2 | EA | 5 | 2 | FA | 4 | 3 | | | - 1 | B+M B | | | . | | R |
| Push Data | PSHA | 1 ~ | • | - | 00 | • | - | 1 | , | | ''^ | 7 | , | 36 | 4 | , | A MSP SP 1 SP | 1 1 | - 4 | ١. | | - |
| | PSHB | ł | | | 1 | | | 1 | | | | | | 37 | 4 | i 1 | B MSP SP 1 SP | 1 1 | | - 1 | | |
| Pull Data | PULA | 1 | | | | | | | | | | | | 32 | 4 | 1 | SP+1 SP MSP A | | | - 1 | | |
| | PULB | 1 | | | | | | 1 | | | | | | 33 | 4 | 1 | SP+1 SP MSP B | | | • | | • |
| Rotate Left | ROL | | | | | | | 69 | 7 | 2 | 79 | 6 | 3 | | | | M) | | • | : | | 3 |
| | ROLA | 1 | | | | | | 1 | | | | | | 49 | 2 | 1 | | | • | :] | : (| آھ |
| | ROLB | l | | | | | | | | | | | | 59 | 2 | 1 | B C 67 - 60 | • | • | : | : [| 6 |
| Rotate Right | ROR | 1 | | | | | | 66 | 7 | 2 | 76 | 6 | 3 | | | i | M) | | • | ٠ | 1 (| <u>آھ</u> |
| | RORA | 1 | | | | | | | | | | | | 46 | 2 | 1 | A} -0 - mmm- | • | • | : | : (| 6 |
| | RORB | l | | | | | | | | | | | | 56 | 2 | 1 | в) с 67 — 60 | | • | : | 1 (| 6 |
| Shift Left Arithmetic | ASL | | | | | | | 68 | 7 | 2 | 78 | 6 | 3 | | | | _ M] | | • | | | 0 |
| | ASLA | | | | | | | | | | | | | 48 | 2 | 1 | A} 0 - mmmp-0 | | - 1 | | | <u>6</u> |
| | ASLB | 1 | | | | | | | | _ | | | | 58 | 2 | 1 | В С 67 60 | 1 1 | • | | | <u>6</u> |
| Shift Right Arithmetic | ASR | 1 | | | | | | 6/ | 1 | 2 | 11 | 6 | 3 | | | . 1 | M) [] + | 1 1 | • | | | 9 |
| | ASRA | | | | | | | | | | | | | 47 | 2 | 1 | ^} \ <u>-unum</u> - 0 | 1 1 | • | : | | <u></u> |
| Ct. to D. to . | ASRB | | | | l | | | | | _ | | _ | | 57 | 2 | 1 | B 67 60 C | | • | | | 9 |
| Shift Right Lagic | LSR | | | | l | | | 64 | 1 | 2 | 74 | 6 | 3 | | | . 1 | М | | | | | <u></u> |
| | LSRA | | | | | | | | | | | | | 44 | 2 | 1 | A 0 | | | | | 9 |
| Const. Access | LSRB | 1 | | | | | | | | - | ١., | | | 54 | 2 | 1 | 0) | | | | | 6 |
| Store Acmitr | STAA | | | | 97 | 4 | 2 | A/ | 6 | 2 | 87 | 5 | 3 | | | | A M | | • | | | R |
| C.,barret | STAB | 00 | , | 2 | D7 | 4 | 2 | E7 | 6 | 2 | F/ | 5 | 3 | | | 1 | ВМ | 1 [| • | | | R |
| Subtract | SUBA | 80 C0 | 2 | 2 | 90 | 3 | 2 | A0 | 5 | 2 | 80 | 4 | 3 | | | 1 | A M A | 1 1 | • | : 1 | | 1 |
| Subtract Acmitrs | SUBB SBA | 1 00 | 2 | 2 | DO | 3 | 2 | EO | 5 | 2 | FO | Ą | 3 | 10 | 2 | , | S M B | 1 1 | • | | . | : |
| Subtract Acmitrs Subtr with Carry | SBCA | 82 | 2 | 2 | 92 | 3 | 2 | A2 | 5 | 2 | B2 | 4 | 3 | 10 | 4 | ' | | 1 | : | : [| :1 | :1 |
| Outer Willi Carry | SBCB | C2 | 2 | 2 | 02 | 3 | 2 | E2 | 5 | 2 | F2 | 4 | 3 | | | - 1 | | 1 1 | | | : | : |
| Transfer Acmitrs | TAB | 1 62 | 2 | - 2 | 02 | 3 | - | 62 | 5 | 2 | 12 | 4 | 3 | 16 | 2 | , | B M (B A B | 1 - 1 | : | - 1 | | |
| | TBA | 1 | | | 1 | | | 1 | | | 1 | | | 17 | 2 | ;] | B A | 1 1 | - 1 | | | R |
| Test, Zero or Minus | TST | 1 | | | 1 | | | 60 | 7 | 2 | 70 | 6 | 3 | l '' | 2 | ' | M 00 | 1 1 | . 1 | | | |
| , Erro or milius | TSTA | 1 | | | 1 | | | 1 30 | , | | 1,0 | J | 3 | 40 | 2 | , | A 00 | | | | | R |
| | TSTB | 1 | | | | | | | | | | | | 50 | 2 | i | B 00 | | | | | R |
| | | | | | | | | | | | | | | | | | | | | | • 1 | -11 |

LEGEND

OP Operation Code (Hexadecimal)

Number of MPU Cycles

- = Number of Program Bytes + Arithmetic Plus
- Arithmetic Minus

- MSP Contents of memory location pointed to be Stack Pointer

Note - Accumulator addressing mode instructions are included in the column for IMPLIED addressing

- + Boolean Inclusive OR

 → Boolean Exclusive OR
- Complement of M
 Transfer Into
 Bit Zero,
- 00 Byte = Zero

- H Half carry from bit 3,
- Interrupt mask Negative (sign bit)

CONDITION CODE SYMBOLS

- Zero (byte) Overflow 2's complement Carry from bit 7
- Reset Always
- Set Always
- Test and set if true, cleared otherwise
- Not Affected

TABLE 4 - INDEX REGISTER AND STACK MANIPULATION INSTRUCTIONS

| | | | | | | | CO | ND | C | 00 | ER | EG | | | | | | | | | | | |
|-----------------------|----------|----|-----|---|----|------|----|----|-----|----|----|-----|---|----|------|----|------------------------------|---|-----|----|----|-----|-----|
| | | 15 | име | D | D | IREC | т_ | 1 | NDE | X | E | XTN | D | IN | PLII | ED |] | 5 | 4 | 3 | 2 | 1 | 0 |
| POINTER OPERATIONS | MNEMONIC | OP | ~ | = | OP | ~ | = | OP | ~ | = | OP | ~ | = | OP | ~ | = | BOOLEAN/ARITHMETIC OPERATION | Н | ١ | N | z | ٧ | C |
| Compare Index Reg | CPX | 8C | 3 | 3 | 90 | 4 | 2 | AC | 6 | 2 | BC | 5 | 3 | | | | XH M, XL - (M + 1) | • | • | 0 | : | (8) | • |
| Decrement Index Reg | DEX | |] | | į | | | | | | | 1 | | 09 | 4 | 1 | x 1 ·x | • | • | • | 1 | • | • |
| Decrement Stack Potr | DES | | 1 | | | 1 | | | | | | | | 34 | 4 | 1 | SP 1 ·SP | • | • | • | • | • | • |
| Increment Index Reg | INX | | | | | l | | | l | | | | | 08 | 4 | 1 | X + 1 · X | • | • | • | 1: | • | • |
| Increment Stack Potr | INS | ĺ | | | ĺ | | | 1 | 1 | | i | ĺ | ì | 31 | 4 | 1 | SP + 1 · SP | • | - 1 | _ | • | • | • |
| Load Index Req | LDX | CE | 3 | 3 | DE | 4 | 2 | EE | 6 | 2 | FE | 5 | 3 | | | | M · XH, (M + 1) · XL | • | • | 9 | 1 | R | • |
| Load Stack Pntr | LDS | 8E | 3 | 3 | 9E | 4 | 2 | AE | 6 | 2 | BE | 5 | 3 | | | 1 | M - SPH, (M + 1) - SPL | • | • | 9 | : | R | • |
| Store Index Reg | STX | | | | DF | 5 | 2 | EF | 7 | 2 | FF | 6 | 3 | | | | XH - M, XL - (M + 1) | • | • | 9 | : | R | • |
| Store Stack Potr | STS | | | | 9F | 5 | 2 | AF | 7 | 2 | BF | 6 | 3 | | j | | SPH - M, SPL - (M + 1) | • | • | 19 | 1: | R | • ' |
| Indx Reg • Stack Potr | TXS | | | | | | | | | | | | | 35 | 4 | 1 | X 1 ·SP | • | • | • | | • | • |
| Stack Potr - Indx Reg | TSX | | | | 1 | | | | | | | | | 30 | 4 | 1 | SP+1 ·X | • | • | • | • | • | • |

TABLE 5 - JUMP AND BRANCH INSTRUCTIONS

| | | | | | | | | | | | | | | | | CON | D C | DDE | REG | |
|--------------------------|----------|-----|-----|-----|----|-----|---|----|-----|---|----|------|---|-------------------------|-----|------|-----|------|-----|---|
| | | RE | LAT | IVE | 1 | NDE | X | E | XTN | D | IN | PLIE | D |] | 5 | 4 | 3 | 2 | 1 | T |
| OPERATIONS | MNEMONIC | OP | ~ | = | OP | ~ | = | OP | ~ | = | OP | ~ | # | BRANCH TEST | Н | 1 | N | Z | ٧ | 1 |
| Branch Always | BRA | 20 | 4 | 2 | | | | | | | | | | None | • | • | • | • | • | T |
| Branch If Carry Clear | BCC | 24 | 4 | 2 | | | 1 | | | | 1 | | | C = 0 | • | • | • | • | • | 1 |
| Branch If Carry Set | BCS | 25 | 4 | 2 | | | | | | | | | | C = 1 | • | • | • | • | • | |
| Branch If = Zero | BEQ | 27 | 4 | 2 | | | i | | | l | | | | Z = 1 | • | • | • | • | • | 1 |
| Branch If ≥ Zero | BGE | 2 C | 4 | 2 | 1 | 1 | | | | 1 | ĺ | 1 | | N ⊕ V = 0 | • | • | • | • | • | 1 |
| Branch If > Zero | BGT | 2E | 4 | 2 | 1 | | | | | 1 | l | 1 | | Z + (N | • | • | | • | • | |
| Branch If Higher | вні | 22 | 4 | 2 | | | | | | | | | | C + Z = 0 | • ' | • | • | • | • | |
| Branch If ≤ Zero | BLE | 2F | 4 | 2 | | | ĺ | | | | | ļ | | Z + (N | • | • | • | • | • | |
| Branch If Lower Or Same | BLS | 23 | 4 | 2 | 1 | | | | | | | | ļ | C + Z = 1 | • | • | | • | • | |
| Branch If < Zero | BLT | 20 | 4 | 2 | | | | | | ŀ | | | 1 | N ⊕ V = 1 | • | • | • | • | • | 1 |
| Branch If Minus | BMI | 28 | 4 | 2 | 1 | | ĺ | | | ĺ | | 1 | 1 | N = 1 | • , | • | | • | • | 1 |
| Branch If Not Equal Zero | BNE | 26 | 4 | 2 | | 1 | | | | | | | İ | Z = 0 | • | • | | • | • | j |
| Branch If Overflow Clear | BVC | 28 | 4 | 2 | | | l | | | | | l | 1 | V = 0 | | • | | • | • | 1 |
| Branch If Overflow Set | BVS | 29 | 4 | 2 | | | | | | | | | | V = 1 | • | • | | • | • | |
| Branch If Plus | BPL | 2A | 4 | 2 |) | 1 | 1 | | | } |] |) | | N = 0 | | • | • | • | • | |
| Branch To Subroutine | BSR | 80 | 8 | 2 | | | ļ | | | l | | | | 1 | | • | • | • | • | |
| Jump | JMP | | | 1 | 6E | 4 | 2 | 7E | 3 | 3 | | | 1 | See Special Operations | • | • | • | • | • | |
| Jump To Subroutine | JSR | | | ĺ | AD | 8 | 2 | BD | 9 | 3 | | ĺ | 1 | (Figure 16) | • | • | • | • | • | 1 |
| No Operation | NOP | | | | | | ļ | | | | 01 | 2 | 1 | Advances Prog Cntr Only | • | • | • | • | • | |
| Return From Interrupt | RTI | | | l | l | 1 | 1 | | | l | 3B | 10 | 1 | | - | | - (| 0) - | | |
| Return From Subroutine | RTS | | | | 1 | l | | | | | 39 | 5 | 1 | | • | • | | • | • | ! |
| Software Interrupt | SWI | | | l | 1 | | | | 1 | | 3F | 12 | 1 | See Special Operations | • | • | • | • | • | |
| Wait for Interrupt | WAI | | | l | 1 | | | | | | 3E | 9 | 1 | (Figure 16) | | (11) | | • | • | |

FIGURE 16 - SPECIAL OPERATIONS

SPECIAL OPERATIONS JSR, JUMP TO SUBROUTINE: Main Program SP Subroutine PC 1st Subr Instr AD = JSR SP-2 [n+2] H INDXD K = Offset* [n+2] L Next Main Instr SP [n+2] H and [n+2] | Form n+2 *K = 8 Bit Unsigned Value Main Program Stack Subroutine PC n BD = JSR SP-2 1st Subr Instr SH = Subr Addr In+3| H SP-1 EXTND n+2 SL = Subr Addr SP [n+3] L (S Formed From S_H and S_L) Next Main Instr l n+3 = Stack Pointer After Execution BSR, BRANCH TO SUBROUTINE PC Main Program <u>sp</u> Subroutine PC → SP-2 1st Subr Instr 8D = BSR n + 2 ± K n SP-1 ± K = Offset* [n+2] H n + 2 Next Main Instr SP [n+2] L *K = 7 Bit Signed Value, n + 2 Formed From (n + 2) H and (n + 2) 1 JMP, JUMP Main Program Main Program <u>PC</u> 6E = JMP 7E = JMP K_H = Next Address K = Offset INDXD K_L = Next Address EXTENDED X + K Next Instruction Next Instruction RTS, RETURN FROM SUBROUTINE Subroutine Stack Main Program PC <u>SP</u> Next Main Instr 39 = RTS SP SP + 1 → SP + 2 NL RTI, RETURN FROM INTERRUPT Interrupt Program Stack Main Program SP <u>PC</u> PC 3B = RTI SP Next Main Instr Condition Code SP + 2 Acmitr B SP + 3 Acmitr A SP + 4 Index Register (XH)

TABLE 6 - CONDITION CODE REGISTER MANIPULATION INSTRUCTIONS

PCL

Index Register (X L)

SP + 5

SP + 6 PCH

→ SP + 7

| | | | | | | | CON | D C | DE | REG | |
|----------------------|----------|----|-----|---|-------------------|---|-----|-----|-----|-----|---|
| | | IN | PLI | D | | 5 | 4 | 3 | 2 | 1 | 0 |
| OPERATIONS | MNEMONIC | OP | ~ | = | BOOLEAN OPERATION | Н | 1 | N | z | ٧ | С |
| Clear Carry | CLC | ОС | 2 | 1 | 0 · C | • | • | • | • | • | R |
| Clear Interrupt Mask | CLI | 0E | 2 | 1 | 0 -1 | • | R | • | • | • | |
| Clear Overflow | CLV | 0A | 2 | 1 | 0 · V | • | • | • | • | R | |
| Set Carry | SEC | OD | 2 | 1 | 1 · C | • | | | • | • | s |
| Set Interrupt Mask | SEI | OF | 2 | 1 | 1 -1 | • | s | • | • | • | |
| Set Overflow | SEV | 08 | 2 | 1 | 1 · v | • | • | | | S | |
| Acmltr A → CCR | TAP | 06 | 2 | 1 | A · CCR | | | (1 | 2)- | | |
| CCR → Acmitr A | TPA | 07 | 2 | 1 | CCR -+ A | | | • | í• | | |

| CONDITION CODE REGISTER NOTES | (Bit set if test is true and cleared otherwise) |
|-------------------------------|---|

| 1 | (Bit V) | Test Result = 10000000? | 7 | (Bit N) | Test Sign bit of most significant (MS) byte = 1? |
|---|---------|---|----|---------|--|
| 2 | (Bit C) | Test Result # 00000000? | 8 | (Bit V) | Test 2's complement overflow from subtraction of MS bytes? |
| 3 | (Bit C) | Test Decimal value of most significant BCD Character greater than nine? | 9 | (Bit N) | Test Result less than zero? (Bit 15 = 1) |
| | | (Not cleared if previously set) | 10 | (AII) | Load Condition Code Register from Stack (See Special Operations) |
| 4 | (Bit V) | Test Operand = 10000000 prior to execution? | 11 | (Bit I) | Set when interrupt occurs If previously set, a Non Maskable |
| 5 | (Bit V) | Test Operand = 011111111 prior to execution? | | | Interrupt is required to exit the wait state |
| 6 | (Bit V) | Test Set equal to result of N⊕C after shift has occurred | 12 | (AII) | Set according to the contents of Accumulator A |

TABLE 7 - INSTRUCTION ADDRESSING MODES AND ASSOCIATED EXECUTION TIMES (Times in Machine Cycle)

| | (Dual Operand) | ACCX | Immediate | Direct | Extended | Indexed | Implied | Relative | | (Dual Operand) | ACCX | Immediate | Direct | Extended | Indexed | Implied |
|------------|----------------|------|-----------|--------|----------|---------|---------|----------|------------|----------------|------|-----------|--------|----------|---------|---------|
| ABA | | • | • | • | • | • | 2 | • | INC | | 2 | • | • | 6 | 7 | • |
| ADC ADD | × | • | 2 | 3 | 4 | 5 5 | • | • | INS INX | | • | • | • | • | • | 4 |
| AND | × | : | 2 | 3 | 4 | 5 | : | : | JMP | | : | : | : | 3 | 4 | • |
| ASL | ~ | 2 | • | • | 6 | 7 | • | | JSR | | • | • | • | 9 | 8 | • |
| ASR | | 2 | • | • | 6 | 7 | • | • | LDA | x | • | 2 | 3 | 4 | 5 | • |
| BCC BCS | | • | • | • | • | • | • | 4 | LDS | | • | 3 | 4 | 5 | 6 | • |
| BEA | | • | • | • | • | • | • | 4 | LDX LSR | | 2 | 3 | 4 | 5 6 | 6 7 | • |
| BGE | | : | : | : | : | : | • | 4 | NEG | | 2 | : | : | 6 | 7 | : |
| BGT | | • | • | • | • | • | • | 4 | NOP | | • | • | • | • | • | 2 |
| ВНІ | | • | • | • | • | • | • | 4 | ORA | x | • | 2 | 3 | 4 | 5 | • |
| BIT | × | • | 2 | 3 | 4 | 5 | • | • | PSH | | • | • | • | • | • | 4 |
| BLE BLS | | • | • | • | • | • | • | 4 | PUL ROL | | 2 | • | • | 6 | 7 | 4 |
| BLS | | • | : | • | • | • | : | 4 | ROR | | 2 | • | : | 6 | 7 | : |
| BMI | | : | : | : | : | : | : | 4 | RTI | | • | : | : | • | | 10 |
| BNE | | • | • | • | • | • | • | 4 | RTS | | • | • | • | • | • | 5 |
| BPL | | • | • | • | • | • | • | 4 | SBA | | • | • | • | • | • | 2 |
| BRA | | • | • | • | • | • | • | 4 | SBC | X | • | 2 | 3 | 4 | 5 | • |
| BSR | | • | • | • | • | • | • | 8 | SEC | | • | • | • | • | • | 2 |
| BVC BVS | | • | : | • | • | • | : | 4 | SEI SEV | | • | • | : | : | : | 2 |
| CBA | | : | : | : | : | : | 2 | • | STA | x | : | : | 4 | 5 | 6 | • |
| CLC | | • | • | • | • | • | 2 | • | STS | - | • | • | 5 | 6 | 7 | • |
| CLI | | • | • | • | • | • | 2 | • | STX | | • | • | 5 | 6 | 7 | • |
| CLR | | 2 | • | • | 6 | 7 | • | • | SUB | X | • | 2 | 3 | 4 | 5 | • |
| CLV | | • | • | • | • | • | 2 | • | SWI | | • | • | • | • | • | 12 |
| CMP COM | X | • | 2 | 3 | 4 | 5 | • | • | TAB | | • | • | • | • | • | 2 |
| CPX | | 2 | 3 | 4 | 6 5 | 7 6 | : | • | TAP TBA | | • | • | • | • | : | 2 |
| DAA | | : | 3 | • | • | • | 2 | : | TPA | | : | • | : | : | : | 2 |
| DEC | | 2 | | • | 6 | 7 | • | | TST | | 2 | | • | 6 | 7 | • |
| DES | | • | • | • | • | • | 4 | • | TSX | | • | • | • | • | • | 4 |
| DEX | | • | • | • | • | • | 4 | • | TSX | | • | • | • | • | • | 4 |
| EOR | X | • | 2 | 3 | 4 | 5 | • | • | WAI | | • | • | • | • | • | 9 |

NOTE Interrupt time is 12 cycles from the end of the instruction being executed, except following a WAT instruction. Then it is 4 cycles.

SUMMARY OF CYCLE-BY-CYCLE OPERATION

Table 8 provides a detailed description of the information present on the address bus, data bus, valid memory address line (VMA), and the read/write line (R/ \overline{W}) during each cycle for each instruction.

This information is useful in comparing actual with expected results during debug of both software and hardware

as the control program is executed. The information is categorized in groups according to addressing modes and number of cycles per instruction. (In general, instructions with the same addressing mode and number of cycles execute in the same manner, exceptions are indicated in the table.)

TABLE 8 - OPERATIONS SUMMARY

| Address Mode | Γ. | Cycle | VMA | | R/W | |
|--------------------|--------------|-------|------|---|----------|---------------------------------|
| and Instructions | Cycles | # | Line | Address Bus | Line | Data Bus |
| IMMEDIATE | | | | · | | |
| ADC EOR ADD LDA | | 1 | 1 | Op Code Address | 1 | Op Code |
| AND ORA | 2 | 2 | 1 | Op Code Address + 1 | 1 | Operand Data |
| BIT SBC CMP SUB | | | | | | |
| CPX | | 1 | 1 | Op Code Address | 1 | Op Code |
| LDS | 3 | 2 | 1 | • | 1 | Operand Data (High Order Byte) |
| LDX | " | 3 | 1 | Op Code Address + 1 | i | Operand Data (Low Order Byte) |
| DIRECT | L | | | Op Code Address + 2 | <u>'</u> | Operand Data (Low Order Byte) |
| ADC EOR | T | 1 | 1 | Op Code Address | 1 | Op Code |
| ADD LDA | | 2 | 1 | • • | 1 | Address of Operand |
| AND ORA BIT SBC | 3 | 3 | 1 | Op Code Address + 1 | 1 | Operand Data |
| CMP SUB | 1 | 3 | ' | Address of Operand | ' | Operand Data |
| CPX | | 1 | 1 | Op Code Address | 1 | Op Code |
| LDS LDX | 4 | 2 | 1 | Op Code Address + 1 | 1 | Address of Operand |
| LDX | - | 3 | 1 | Address of Operand | 1 | Operand Data (High Order Byte) |
| | | 4 | 1 | Operand Address + 1 | 1 | Operand Data (Low Order Byte) |
| STA | | 1 | 1 | Op Code Address | 1 | Op Code |
| | 4 | 2 | 1 | Op Code Address + 1 | 1 | Destination Address |
| | | 3 | 0 | Destination Address | 1 | Irrelevant Data (Note 1) |
| | 1 | 4 | 1 | Destination Address | 0 | Data from Accumulator |
| STS | | 1 | 1 | Op Code Address | 1 | Op Code |
| STX | 1 | 2 | 1 | Op Code Address + 1 | 1 | Address of Operand |
| | 5 | 3 | 0 | Address of Operand | 1 | Irrelevant Data (Note 1) |
| | 1 | 4 | 1 | Address of Operand | 0 | Register Data (High Order Byte) |
| | | 5 | 1 | Address of Operand + 1 | 0 | Register Data (Low Order Byte) |
| INDEXED | | | | | | |
| JMP | 1 | 1 | 1 | Op Code Address | 1 | Op Code |
| | 4 | 2 | 1 | Op Code Address + 1 | 1 | Offset |
| | · · | 3 | 0 | Index Register | 1 | Irrelevant Data (Note 1) |
| | | 4 | 0 | Index Register Plus Offset (w/o Carry) | 1 | Irrelevant Data (Note 1) |
| ADC EOR | | 1 | 1 | Op Code Address | 1 | Op Code |
| ADD LDA AND ORA | ļ | 2 | 1 | Op Code Address + 1 | 1 | Offset |
| BIT SBC | 5 | 3 | 0 | Index Register | 1 | Irrelevant Data (Note 1) |
| CMP SUB | 1 | 4 | 0 | Index Register Plus Offset (w/o Carry) | 1 | Irrelevant Data (Note 1) |
| | | 5 | 1 | Index Register Plus Offset | 1 | Operand Data |
| CPX | | 1 | 1 | Op Code Address | 1 | Op Code |
| LDS LDX | l | 2 | 1 | Op Code Address + 1 | 1 | Offset |
| | 6 | 3 | 0 | Index Register | 1 | Irrelevant Data (Note 1) |
| | | 4 | 0 | Index Register Plus Offset (w/o Carry) | 1 | Irrelevant Data (Note 1) |
| | | 5 | 1 | Index Register Plus Offset | 1 | Operand Data (High Order Byte) |
| | | 6 | 1 | Index Register Plus Offset + 1 | 1 | Operand Data (Low Order Byte) |

TABLE 8 - OPERATIONS SUMMARY (CONTINUED)

| Address Mode and Instructions | Cycles | Cycle | VMA Line | Address Bus | R/W Line | Data Bus |
|-------------------------------|--------------|----------|--------------------|--|-------------|---------------------------------------|
| INDEXED (Continued) | - Cy5.03 | <u> </u> | | Addition Day | | Deta Du3 |
| STA | <u> </u> | 1 | 1 | Op Code Address | 1 | Op Code |
| | l | 2 | 1 1 | Op Code Address + 1 | 1 | Offset |
| | 6 | 3 | 0 | Index Register | 1 | Irrelevant Data (Note 1) |
| } | • | 4 | 0 | Index Register Plus Offset (w/o Carry) | 1 | Irrelevant Data (Note 1) |
| | ļ | 5 | 0 | Index Register Plus Offset | 1 | Irrelevant Data (Note 1) |
| | j | 6 | 1 | Index Register Plus Offset | 0 | Operand Data |
| ASL LSR | | 1 | 1 | Op Code Address | 1 | Op Code |
| ASR NEG | | 2 | 1 | Op Code Address + 1 | 1 | Offset |
| CLR ROL COM ROR | | 3 | 0 | Index Register | 1 , | Irrelevant Data (Note 1) |
| DEC TST | 7 | 4 | 0 | Index Register Plus Offset (w/o Carry) | 1 | Irrelevant Data (Note 1) |
| INC | ļ | 5 | 1 | Index Register Plus Offset | 1 | Current Operand Data |
| | ł | 6 | 0 | Index Register Plus Offset | 1 1 | Irrelevant Data (Note 1) |
| | ļ | 7 | 1/0 | Index Register Plus Offset | 0 | New Operand Data (Note 3) |
| | | | (Note 3) | The Control of the Co | | New Operand Data (Note 3) |
| STS | | 1 | 1 | Op Code Address | 1 | Op Code |
| STX | | 2 | 1 1 | Op Code Address + 1 | 1 | Offset |
| | 7 | 3 | 0 | Index Register | 1 1 | Irrelevant Data (Note 1) |
| | | 4 | 0 | Index Register Plus Offset (w/o Carry) | 1 | Irrelevant Data (Note 1) |
| | | 5 | 0 | Index Register Plus Offset | 1 1 | Irrelevant Data (Note 1) |
| | | 6 | 1 | Index Register Plus Offset | 0 | Operand Data (High Order Byte) |
| | | 7 | 1 | Index Register Plus Offset + 1 | 0 | Operand Data (Low Order Byte) |
| JSR | | 1 | 1 | Op Code Address | 1 | Op Code |
| | | 2 | 1 | Op Code Address + 1 | 1 | Offset |
| | | 3 | 0 | Index Register | 1 | Irrelevant Data (Note 1) |
| | 8 | 4 | 1 | Stack Pointer | 0 | Return Address (Low Order Byte) |
| | | 5 | 1 | Stack Pointer - 1 | 0 | Return Address (High Order Byte) |
| | | 6 | 0 | Stack Pointer – 2 | 1 | Irrelevant Data (Note 1) |
| | } | 7 | 0 | Index Register | 1 | Irrelevant Data (Note 1) |
| | ļ | 8 | 0 | Index Register Plus Offset (w/o Carry) | 1 | Irrelevant Data (Note 1) |
| EXTENDED | | | ـــــــا | | | |
| JMP | | 1 | 1 | Op Code Address | 1 | Op Code |
| | 3 | 2 | 1 | Op Code Address + 1 | 1 | Jump Address (High Order Byte) |
| | | 3 | 1 | Op Code Address + 2 | 1 | Jump Address (Low Order Byte) |
| ADC EOR | | 1 | 1 | Op Code Address | 1 | Op Code |
| ADD LDA | | 2 | 1 | Op Code Address + 1 | 1 | Address of Operand (High Order Byte) |
| AND ORA | 4 | 3 | 1 | Op Code Address + 2 | 1 | Address of Operand (Low Order Byte) |
| CMP SUB | | 4 | 1 | Address of Operand | 1 | Operand Data |
| CPX | | 1 | 1 | Op Code Address | 1 | Op Code |
| LDS | | 2 | 1 | Op Code Address + 1 | 1 | Address of Operand (High Order Byte) |
| LDX | 5 | 3 | 1 | Op Code Address + 2 | 1 | Address of Operand (Low Order Byte) |
| | | 4 | 1 | Address of Operand | 1 | Operand Data (High Order Byte) |
| | | 5 | 1 | Address of Operand + 1 | 1 | Operand Data (Low Order Byte) |
| STA A | | 1 | 1 | Op Code Address | 1 | Op Code |
| STA B | | 2 | 1 | Op Code Address + 1 | 1 | • |
| ' | 5 | 3 | 1 | Op Code Address + 1 Op Code Address + 2 | 1 | Destination Address (High Order Byte) |
| | 5 | 4 | 0 | | 1 | Destination Address (Low Order Byte) |
| | | 5 | | Operand Destination Address | 1 1 | Irrelevant Data (Note 1) |
| ACL LCD | | 1 | 1 | Operand Destination Address | 0 | Data from Accumulator |
| ASL LSR ASR NEG | | 1 | | Op Code Address | 1 | Op Code |
| CLR ROL | | 2 | 1 | Op Code Address + 1 | 1 | Address of Operand (High Order Byte) |
| COM ROR DEC TST | 6 | 3 | 1 | Op Code Address + 2 | 1 | Address of Operand (Low Order Byte) |
| INC | | 4 | 1 | Address of Operand | 1 | Current Operand Data |
| | | 5 | 0 | Address of Operand | 1 | Irrelevant Data (Note 1) |
| | | 6 | 1/0 (Note 3) | Address of Operand | 0 | New Operand Data (Note 3) |

TABLE 8 — OPERATIONS SUMMARY (CONTINUED)

| Address Mode and Instructions | Cycles | Cycle # | VMA Line | Address Bus | R/W Line | Data Bus |
|-------------------------------|--------|------------|-------------|-----------------------------|--------------|---|
| EXTENDED (Continued) | | | | | | |
| STS | | 1 | 1 | Op Code Address | 1 | Op Code |
| 317 | | 2 | 1 | Op Code Address + 1 | 1 | Address of Operand (High Order Byte) |
| | 6 | 3 | 1 1 | Op Code Address + 2 | 1 | Address of Operand (Low Order Byte) |
| | | 4 | 0 | Address of Operand | 1 | Irrelevant Data (Note 1) |
| | | 5 | 1 | Address of Operand | 0 | Operand Data (High Order Byte) |
| | | 6 | 1 | Address of Operand + 1 | 0 | Operand Data (Low Order Byte) |
| JSR | | 1 | 1 | Op Code Address | 1 | Op Code |
| | | 2 | 1 1 | Op Code Address + 1 | 1 | Address of Subroutine (High Order Byte) |
| | | 3 | 1 1 | Op Code Address + 2 | 1 | Address of Subroutine (Low Order Byte) |
| | | 4 | 1 | Subroutine Starting Address | 1 | Op Code of Next Instruction |
| | 9 | 5 | 1 | Stack Pointer | 0 | Return Address (Low Order Byte) |
| |] | 6 | 1 1 | Stack Pointer — 1 | 0 | Return Address (High Order Byte) |
| | | 7 | 0 | Stack Pointer – 2 | 1 | Irrelevant Data (Note 1) |
| | 1 | 8 | 0 | Op Code Address + 2 | 1 | Irrelevant Data (Note 1) |
| | 1 | 9 | 1 | Op Code Address + 2 | 1 | Address of Subroutine (Low Order Byte) |
| INHERENT | · | | | | | |
| ABA DAA SEC | | 1 | 1 | Op Code Address | 1 | Op Code |
| ASL DEC SEI | 2 | 2 | 1 | Op Code Address + 1 | 1 | Op Code of Next Instruction |
| ASR INC SEV CBA LSR TAB | | 1 | | | | |
| CLC NEG TAP | Ì | | | | | |
| CLI NOP TBA CLR ROL TPA | 1 | | | | | |
| CLV ROR TST | | | | | | |
| COM SBA | | 1 | | 0-0-1-0-1-0 | | On Code |
| DES DEX | | 1 | 1 | Op Code Address | | Op Code |
| INS | 4 | 2 | 1 | Op Code Address + 1 | 1 | Op Code of Next Instruction Irrelevant Data (Note 1) |
| INX | | 3 | 0 | Previous Register Contents | | |
| | | 4 | 0 | New Register Contents | 1 | Irrelevant Data (Note 1) |
| PSH | | 1 | 1 | Op Code Address | 1 | Op Code |
| | 4 | 2 | 1 | Oρ Code Address + 1 | 1 | Op Code of Next Instruction |
| | | 3 | 1 | Stack Pointer | 0 | Accumulator Data |
| | | 4 | 0 | Stack Pointer — 1 | 1 | Accumulator Data |
| PUL | İ | 1 | 1 | Op Code Address | 1 | Op Code |
| | 4 | 2 | 1 | Op Code Address + 1 | 1 | Op Code of Next Instruction |
| | | 3 | 0 | Stack Pointer | 1 | Irrelevant Data (Note 1) |
| | | 4 | 1 | Stack Pointer + 1 | 1 | Operand Data from Stack |
| TSX | | 1 | 1 | Op Code Address | 1 | Op Code |
| | 4 | 2 | 1 | Op Code Address + 1 | 1 | Op Code of Next Instruction |
| | , . | 3 | 0 | Stack Pointer | 1 | Irrelevant Data (Note 1) |
| | | 4 | 0 | New Index Register | 1 | Irrelevant Data (Note 1) |
| TXS | | 1 | 1 | Op Code Address | 1 | Op Code |
| | 4 | 2 | 1 | Op Code Address + 1 | 1 | Op Code of Next Instruction |
| | 1 - | 3 | 0 | Index Register | 1 | Irrelevant Data |
| | | 4 | 0 | New Stack Pointer | 1 | Irrelevant Data |
| RTS | | 1 | 1 | Op Code Address | 1 | Op Code |
| | 1 | 2 | 1 | Op Code Address + 1 | 1 | Irrelevant Data (Note 2) |
| | 5 | 3 | 0 | Stack Pointer | 1 | Irrelevant Data (Note 1) |
| | | 4 | 1 | Stack Pointer + 1 | 1 | Address of Next Instruction (High Order Byte) |
| | | 5 | 1 | Stack Pointer + 2 | 1 | Address of Next Instruction (Low Order Byte) |

TABLE 8 - OPERATIONS SUMMARY (CONCLUDED)

D/W

Cuelo VMA

| Address Mode and Instructions | Cycles | Cycle | VMA Line | Address Bus | R/W Line | Data Bus |
|-------------------------------|----------|----------|-------------|--------------------------------|-------------|--|
| INHERENT (Continued) | Oyeles | <u> </u> | | | | |
| WAI | · | 1 | 1 | Op Code Address | 1 | Op Code |
| | | 2 | 1 | Op Code Address + 1 | 1 | Op Code of Next Instruction |
| | 1 | 3 | 1 | Stack Pointer | 0 | Return Address (Low Order Byte) |
| | | 4 | 1 | Stack Pointer - 1 | 0 | Return Address (High Order Byte) |
| i | 9 | 5 | 1 | Stack Pointer — 2 | 0 | Index Register (Low Order Byte) |
| | | 6 | 1 | Stack Pointer - 3 | 0 | Index Register (High Order Byte) |
| 1 | | 7 | 1 | Stack Pointer 4 | 0 | Contents of Accumulator A |
| | l | 8 | 1 | Stack Pointer — 5 | 0 | Contents of Accumulator B |
| | 1 | 9 | 1 | Stack Pointer - 6 | 1 | Contents of Cond. Code Register |
| RTI | | 1 | 1 | Op Code Address | 1 | Op Code |
| | } | 2 | 1 | Op Code Address + 1 | 1 | Irrelevant Data (Note 2) |
| | l | 3 | 0 | Stack Pointer | 1 | Irrelevant Data (Note 1) |
| | <u> </u> | 4 | 1 | Stack Pointer + 1 | 1 | Contents of Cond. Code Register from Stack |
| | 10 | 5 | 1 | Stack Pointer + 2 | 1 | Contents of Accumulator B from Stack |
| | | 6 | 1 | Stack Pointer + 3 | 1 | Contents of Accumulator A from Stack |
| | | 7 | 1 | Stack Pointer + 4 | 1 | Index Register from Stack (High Order Byte) |
| | | 8 | 1 | Stack Pointer + 5 | 1 | Index Register from Stack (Low Order Byte) |
| | | 9 | 1 | Stack Pointer + 6 | 1 | Next Instruction Address from Stack (High Order Byte) |
| | | 10 | 1 | Stack Pointer + 7 | 1 | Next Instruction Address from Stack (Low Order Byte) |
| SWI | | 1 | 1 | Op Code Address | 1 | Op Code |
| | 1 | 2 | 1 | Op Code Address + 1 | 1 | Irrelevant Data (Note 1) |
| | | 3 | 1 | Stack Pointer | 0 | Return Address (Low Order Byte) |
| | 1 | 4 | 1 | Stack Pointer — 1 | 0 | Return Address (High Order Byte) |
| | | 5 | 1 | Stack Pointer — 2 | 0 | Index Register (Low Order Byte) |
| | 12 | 6 | 1 | Stack Pointer - 3 | 0 | index Register (High Order Byte) |
| ! | | 7 | 1 | Stack Pointer — 4 | 0 | Contents of Accumulator A |
| | | 8 | 1 | Stack Pointer - 5 | 0 | Contents of Accumulator B |
| | | 9 | 1 | Stack Pointer — 6 | 0 | Contents of Cond. Code Register |
| | | 10 | 0 | Stack Pointer — 7 | 1 | Irrelevant Data (Note 1) |
| | | 11 | 1 | Vector Address FFFA (Hex) | 1 | Address of Subroutine (High Order Byte) |
| | | 12 | 1 | Vector Address FFFB (Hex) | 1 | Address of Subroutine (Low Order Byte) |
| RELATIVE | | , | | | | |
| BCC BHI BNE | | 1 | 1 | Op Code Address | 1 | Op Code |
| BCS BLE BPL BEQ BLS BRA | 4 | 2 | 1 | Op Code Address + 1 | 1 | Branch Offset |
| BGE BLT BVC | | 3 | 0 | Op Code Address + 2 | 1 | Irrelevant Data (Note 1) |
| BGT BMI BVS | | 4 | 0 | Branch Address | 1 | Irrelevant Data (Note 1) |
| BSR | | 1 | 1 | Op Code Address | 1 | Op Code |
| | | 2 | 1 | Op Code Address + 1 | 1 | Branch Offset |
| | | 3 | 0 | Return Address of Main Program | 1 | Irrelevant Data (Note 1) |
| | 8 | 4 | 1 | Stack Pointer | 0 | Return Address (Low Order Byte) |
| | _ | 5 | 1 | Stack Pointer - 1 | 0 | Return Address (High Order Byte) |
| | | 6 | 0 | Stack Pointer - 2 | 1 | Irrelevant Data (Note 1) |
| | | 7 | 0 | Return Address of Main Program | 1 | Irrelevant Data (Note 1) |
| | | 8 | 0 | Subroutine Address (Note 4) | 1 | Irrelevant Data (Note 1) |

NOTES

- 1 If device which is addressed during this cycle uses VMA, then the Data Bus will go to the high-impedance three-state condition Depending on bus capacitance, data from the previous cycle may be retained on the Data Bus
- Data is ignored by the MPU
 For TST, VMA=0 and Operand data does not change
- 4 MS Byte of Address Bus = MS Byte of Address of BSR instruction and LS Byte of Address Bus = LS Byte of Sub-Routine Address



MC6805P2

Advance Information

8-BIT MICROCOMPUTER UNIT

The MC6805P2 Microcomputer Unit (MPU) is a member of the M6805 Family of low-cost single-chip microcomputers. This 8-bit microcomputer contains a CPU, on-chip CLOCK, ROM, RAM, I/O, and TIMER. It is designed for the user who needs an economical microcomputer with the proven capabilities of the M6800-based instruction set A comparison of the key features of several members of the M6805 Family is shown on the last page of this data sheet. The following are some of the hardware and software highlights of the MC6805P2 MCU.

HARDWARE FEATURES:

- 8-Bit Architecture
- 64 Bytes of RAM
- Memory Mapped I/O
- 1100 Bytes of User ROM
- 20 TTL/CMOS Compatible Bidirectional I/O Lines (8 Lines are LED Compatible)
- On-Chip Clock Generator
- Self-Check Mode
- Zero Crossing Detection
- Master Reset
- Complete Development System Support on EXORciser®
- 5 V Single Supply

SOFTWARE FEATURES:

- Similar to M6800 Family
- Byte Efficient Instruction Set
- Easy to Program
- True Bit Manipulation
- Bit Test and Branch Instruction
- Versatile Interrupt Handling
- Versatile Index Register
- Powerful Indexed Addressing for Tables
- Full Set of Conditional Branches
- Memory Usable as Register/Flags
- Single Instruction Memory Examine/Change
- 10 Powerful Addressing Modes
- All Addressing Modes Apply to ROM, RAM, and I/O

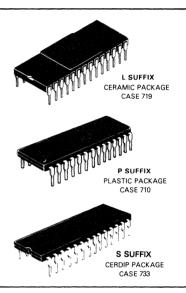
USER SELECTABLE OPTIONS:

- Internal 8-Bit Timer with Selectable Clock Source (External Timer Input or Internal Machine Clock)
- Timer Prescaler Option (7 Bits 2^N)
- 8 Bidirectional I/O Lines with TTL or TTL/CMOS Interface Option
- Crystal or Low-Cost Resistor Oscillator Option
- Low Voltage Inhibit Option
- 4 Vectored Interrupts; Timer, Software, and 2 External

HMOS

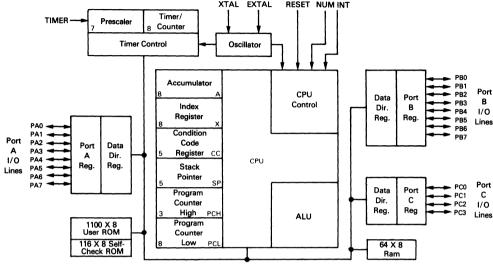
(HIGH DENSITY N-CHANNEL, SILICON-GATE DEPLETION LOAD)

8-BIT MICROCOMPUTER



| FIGURE 1 — PIN ASSIGNMENTS | | | | |
|----------------------------|-----|-----------------|--|--|
| v _{ss} r | 1 • | 28 TRESET | | |
| INT [| 2 | 27 1 PA7 | | |
| ^V сс г | 3 | 26 1 PA6 | | |
| EXTAL C | 4 | 25 1 PA5 | | |
| XTAL [| 5 | 24 1 PA4 | | |
| NUM | 6 | 23 1 PA3 | | |
| TIMER [| 7 | 22 1 PA2 | | |
| PC0 [| 8 | 21 1 PA1 | | |
| PC1 [| 9 | 20 1 PA0 | | |
| PC2 [| 10 | 19 1 PB7 | | |
| PC3 [| 11 | 18 7 PB6 | | |
| PB0 [| 12 | 17 1 PB5 | | |
| PB1 [| 13 | 16 1 PB4 | | |
| PB2 [| 14 | 15 1 PB3 | | |
| | | | | |

FIGURE 2 - MC6805P2 HMOS MICROCOMPUTER BLOCK DIAGRAM XTAL EXTAL RESET NUM INT Timer/ Counter



MAXIMUM RATINGS

| Rating | Symbol | Value | Unit |
|------------------------------|------------------|----------------|------|
| Supply Voltage | VCC | -0.3 to $+7.0$ | V |
| Input Voltage (Except Pin 6) | V _{in} | -0.3 to $+7.0$ | V |
| Operating Temperature Range | TA | 0 to 70 | °C |
| Storage Temperature Range | T _{stg} | -55 to +150 | °C |
| Junction Temperature | | | |
| Plastic |) | 150 | |
| Ceramic | Tj | 175 | °C |
| Cerdip | | 175 | |

This device contains circuitry to protect the inputs against damage due to high static voltages or electric fields, however, it is advised that normal precautions be taken to avoid application of any voltage higher than maximum rated voltages to this highimpedance circuit. For proper operation it is recommended that V_{In} and V_{out} be constrained to the range $V_{SS} \leq (V_{in} \text{ or } V_{out})$ ≤V_{CC} Reliability of operation is enhanced if unused inputs are tied to an appropriate logic voltage level (e.g., eitner VSS or VCC)

(2)

THERMAL CHARACTERISTICS

| Characteristic | Symbol | Value | Unit |
|--------------------|---------------|-------|------|
| Thermal Resistance | | | |
| Plastic | | 120 | |
| Ceramic | θ_{JA} | 50 | °C/W |
| Cerdip | | 60 | |

POWER CONSIDERATIONS

The average chip-junction temperature, TJ, in °C can be obtained from

$$T_{J} = T_{A} + (P_{D} \bullet \theta_{JA}) \tag{1}$$

Where:

TA = Ambient Temperature, °C

 θ JA = Package Thermal Resistance, Junction-to-Ambient, °C/W

PD = PINT + PPORT

PINT≡ICC×VCC, Watts - Chip Internal Power

PPORT≡Port Power Dissipation, Watts - User Determined

drive Darlington bases or sink LED loads

An approximate relationship between PD and TJ (if PPORT is neglected) is

Solving equations 1 and 2 for K gives.

 $K = P_D \bullet (T_A + 273 \degree C) + \theta_{JA} \bullet P_D^2$

Where K is a constant pertaining to the particular part. K can be determined from equation 3 by measuring PD (at equilibrium) for a known TA. Using this value of K the values of PD and TJ can be obtained by solving equations (1) and (2) iteratively for any value of TA.

ELECTRICAL CHARACTERISTICS $(V_{CC} = +5.25 \text{ Vdc} \pm 0.5 \text{ Vdc}, V_{SS} = \text{GND}, T_A = 0^{\circ} \text{ to } 70^{\circ}\text{C}$ unless otherwise noted)

| Characteristic | Symbol | Min | Тур | Max | Unit |
|---|------------------|---------------------|-----|------|----------------------|
| Input High Voltage | | | | | |
| RESET (4 75≤V _{CC} ≤5 75) | | 40 | | Vcc | |
| (V _{CC} <4 75) | 1 | V _{CC} -05 | - | Vcc | |
| INT (4 75≤V _{CC} ≤5 75) | VIH | 40 | * | vcc | V |
| (V _{CC} <4 75) | 1 | V _{CC} -05 | * | Vcc | |
| All Other | | 20 | _ | Vcc | |
| Input High Voltage Timer | | | | | |
| Timer Mode | ViH | 20 | - | Vcc | V |
| Self-Check Mode | | | 90 | 15 0 | |
| Input Low Voltage | | | | | |
| RESET | 1 | -03 | - | 0.8 | ł |
| ĪNT | VIL | -03 | * | 15 | V |
| All Other | | -03 | | 0.8 | |
| RESET Hysteresis Voltage (See Figures 11, 12, and 13) | | } | | } | |
| "Out of Reset" | VIRES+ | 21 | _ | 40 | V |
| "Into Reset" | VIRES- | 0.8 | - | 20 | |
| INT Zero Crossing Input Voltage, Through a Capacitor | VINT | 20 | - | 40 | V _{a-c p-p} |
| Internal Power Dissipation—No Port Loading V _{CC} =5 75 V, T _A =0°C | PINT | | 400 | 690 | mW |
| Input Capacitance | | | | | |
| EXTAL | C _{in} | - | 25 | - | рF |
| All Other | | | 10 | | |
| Low Voltage Recover | V _{LVR} | _ | _ | 4 75 | V |
| Low Voltage Inhibit | V_{LVI} | _ | 35 | _ | V |
| Input Current | | | | | |
| TIMER (V _{IN} =0 4 V) | 1 | - | - | 20 | l |
| INT (V _{In} = 2 4 V to V _{CC}) | 1 | - | 20 | 50 | 1 |
| EXTAL (V _{In} =24 V to V _{CC} , Crystal Option) | l _{in} | - 1 | - | 10 | μΑ |
| (V _{In} =0 4 V, Crystal Option) | 1 | - | - | 1600 | |
| RESET (V _{In} =0 8 V) | i | -40 | | 50 | |
| (External Capacitor Charging Current) | | | | | |

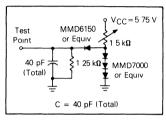
^{*}Due to internal biasing, this input (when unused) floats to approximately 2 0 Vdc

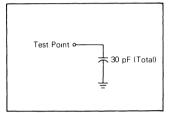
PORT DC ELECTRICAL CHARACTERISTICS (V_{CC} = +5 25 Vdc±0 5 Vdc, V_{SS} = GND, T_A = 0° to 70°C unless otherwise noted)

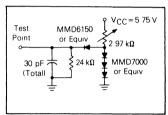
| Characteristic | Symbol | Min | Тур | Max | Unit |
|--|--------------------------|-----|-----|-----------------|------|
| Port A with | CMOS Drive Enabled | | | | |
| Output Low Voltage, I _{Load} = 1 6 mA | V _{OL} | _ | - | 0 4 | ٧ |
| Output High Voltage, I _{Load} = -100 μA | Voн | 2 4 | - | | V |
| Output High Voltage, I _{Load} = -10 μA | Voн | 3 5 | | - 1 | V |
| Input High Voltage, I _{Load} = -300 µA (max) | V _{IH} | 20 | | VCC | V |
| Input Low Voltate, $I_{Load} = -500 \mu\text{A}$ (max) | VIL | 03 | _ | 0.8 | V |
| Hi-Z State Input Current (V _{In} =20 V to V _{CC}) | liн | | - | -300 | μΑ |
| Hi-Z State Input Current (V _{In} =0 4 V) | I | | _ | 500 | μΑ |
| | Port B | | | | |
| Output Low Voltage, I _{Load} =3 2 mA | V _{OL} | - | - | 0 4 | V |
| Output Low Voltage, I _{Load} = 10 mA (sink) | V _{OL} | _ | _ | 10 | ٧ |
| Output High Voltage, I _{Load} = -200 μA | Voн | 2 4 | _ | | ٧ |
| Darlington Current Drive (Source), V _O = 1 5 V | loн | -10 | _ | - 10 | mA |
| Input High Voltage | VIH | 2 0 | | Vcc | V |
| Input Low Voltage | V _{IL} | -03 | - | 0.8 | V |
| Hı-Z State Input Current | ITSI | | 2 | 20 | μΑ |
| Port C and Port A | with CMOS Drive Disabled | | | | |
| Output Low Voltage, I _{Load} = 1 6 mA | V _{OL} | - | - | 0 4 | V |
| Output High Voltage, I _{Load} = -100 μA | Voн | 2 4 | _ | - | V |
| Input High Voltage | V _{IH} | 20 | - | V _{CC} | V |
| Input Low Voltage | V _{IL} | -03 | - | 0.8 | ٧ |
| Hı-Z State Input Current | ^I TSI | _ | 2 | 20 | μΑ |

| Characteristic | Symbol | Min | Тур | Max | Unit |
|--|------------------|------------------------|-----|-----|------|
| Oscillator Frequency | fosc | 0.4 | | 4.2 | MHz |
| Cycle Time (4/f _{osc}) | tcyc | 0 95 | - | 10 | μS |
| INT and TIMER Pulse Width | tWL,tWH | t _{CyC} + 250 | | | ns |
| RESET Pulse Width | [†] RWL | t _{CyC} + 250 | - | - | ns |
| RESET Delay Time (External Capacitance = 1 0 μF) | t _{RHL} | - | 100 | - | ms |
| INT Zero Crossing Detection Input Frequency (±5° Accuracy) | fINT | 0 03 | - | 10 | kHz |
| External Clock Input Duty Cycle (EXTAL) | - | 40 | 50 | 60 | % |

FIGURE 3 — TTL EQUIVALENT TEST LOAD FIGURE 4 — CMOS EQUIVALENT TEST LOAD FIGURE 5 — TTL EQUIVALENT TEST LOAD (PORT B) (PORT A) (PORTS A AND C)







SIGNAL DESCRIPTION

The input and output signals for the MCU, shown in Figure 1, are described in the following paragraphs

 \textbf{V}_{CC} AND \textbf{V}_{SS} - Power is supplied to the MCU using these two pins $\,$ V $_{CC}$ is power and $\,$ V $_{SS}$ is the ground connection

 $\overline{\text{INT}}$ — This pin provides the capability for asynchronously applying an external interrupt to the MCU Refer to INTER-RUPTS for additional information

XTAL AND EXTAL — These pins provide connections to the on-chip clock oscillator circuit. A crystal, a resistor, or an external signal depending on the user selectable manufacturing mask option, can be connected to these pins to provide a system clock source with various stability/cost tradeoffs. Lead lengths and stray capacitance on these two pins should be minimized. Refer to INTERNAL CLOCK GENERATOR OPTIONS for recommendations about these inputs.

TIMER — This pin allows an external input to be used to decrement the internal timer circuitry. Refer to TIMER for additional information about the timer circuitry.

RESET — This pin allows resetting of the MCU at times other than the automatic resetting capability already in the MCU Refer to RESETS for additional information

NUM-This pin is not for user application and must be connected to V_{SS}

INPUT/OUTPUT LINES (A0-A7, B0-B7, C0-C3) — These 20 lines are arranged into two 8-bit ports (A and B) and one

4-bit port (C) All lines are programmable as either inputs or outputs under software control of the data direction registers Refer to INPUTS/OUTPUTS for additional information

MEMORY

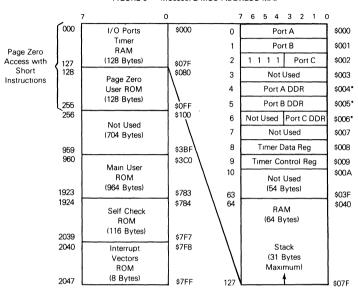
As shown in Figure 6, the MCU is capable of addressing 2048 bytes of memory and I/O registers with its program counter The MC6805P2 MCU has implemented 128 of these locations. This consists of 1100 bytes of user ROM, 116 bytes of self-check ROM, 64 bytes of user RAM, 6 bytes of port I/O, and 2 timer registers.

The stack area is used during the processing of interrupt and subroutine calls to save the processor state. The register contents are pushed onto the stack in the order shown in Figure 7. Because the stack pointer decrements during pushes, the low order byte (PCL) of the program counter is stacked first, then the high order three bits (PCH) are stacked. This ensures that the program counter is loaded correctly, during pulls from the stack, since the stack pointer increments during pulls. A subroutine call results in only the program counter (PCL, PCH) contents being pushed onto the stack. The remaining CPU registers are not pushed.

CENTRAL PROCESSING UNIT

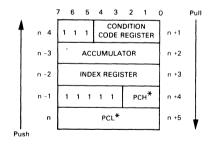
The CPU of the M6805 Family is implemented in dependently from the I/O or memory configuration. Consequently, it can be treated as an independent central processor communication with I/O and memory via internal address, data, and control buses.

FIGURE 6 - MC6805P2 MCU ADDRESS MAP



^{*}Caution (DDRs) are write-only, they read as \$FF

FIGURE 7 — INTERRUPT STACKING ORDER



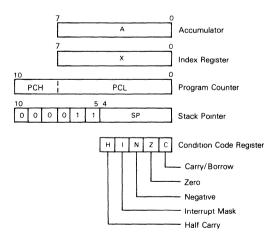
^{*}For subroutine calls, only PCL and PCH are stacked

REGISTERS

The M6805 Family CPU has five registers available to the programmer. They are shown in Figure 8 and are explained in the following paragraphs.

ACCUMULATOR (A) — The accumulator is a general purpose 8-bit register used to hold operands and results of arithmetic calculations or data manipulations

FIGURE 8 — PROGRAMMING MODEL



1

INDEX REGISTER (X) — The index register is an 8-bit register used for the indexed addressing mode. It contains an 8-bit value that may be added to an instruction value to create an effective address. The index register can also be used for data manipulations using the read/modify/write instructions. The index register may also be used as a temporary storage area.

PROGRAM COUNTER (PC) — The program counter is an 11-bit register that contains the address of the next instruction to be executed

STACK POINTER (SP) — The stack pointer is an 11-bit register that contains the address of the next free location on the stack. Initially, the stack pointer is set to location \$97F and is decremented as data is being pushed onto the stack and incremented as data is being pulled from the stack. The six most significant bits of the stack pointer are permanently set to 000011 During a MCU reset or the Reset Stack Pointer (RSP) instruction, the stack pointer is set to location \$07F Subroutines and interrupts may be nested down to location \$061–(31 bytes maximum) which allows the programmer to use up to 15 levels of subroutine calls

CONDITION CODE REGISTER (CC) — The condition code register is a 5-bit register in which four bits are used to indicate the results of the instruction just executed. These bits can be individually tested by a program and specific action taken as a result of their state. Each individual condition code register bit is explained in the following paragraphs.

 $\mbox{ Half Carry (H)} - \mbox{ Set during ADD and ADC instructions to indicate that a carry occurred between bits 3 and 4}$

Interrupt (I) — This bit is set to mask (disable) the timer and external interrupt (INT). If an interrupt occurs while this

bit is set the interrupt is latched and is processed as soon as the interrupt bit is cleared

Negative (N) — Used to indicate that the result of the last arithmetic, logical or data manipulation was negative (bit 7 in result equal to a logical one)

Zero (Z) — Used to indicate that the result of the last arithmetic, logical or data manipulation was zero

Carry/Borrow (C) — Used to indicate that a carry or borrow out of the arithmetic logic unit (ALU) occurred during the last arithmetic operation. This bit is also affected during bit test and branch instructions plus shifts and rotates.

TIMER

The 8-bit counter may be loaded under program control and is decremented toward zero by the clock input (prescaler output). When the timer reaches zero, the timer interrupt request bit (bit 7) in the Timer Control Register (TCR) is set The timer interrupt can be masked (disabled) by setting the timer interrupt mask bit (bit 6) in the TCR. The interrupt bit (II-bit) in the Condition Code Register also prevents a timer interrupt from being processed. The MCU responds to this interrupt by saving the present CPU state in the stack, fetching the timer interrupt vector from locations \$7F8 and \$7F9 and executing the interrupt routine, see the INTER-RUPTS section. The TIMER INTERRUPT REQUEST BIT MUST BE CLEARED BY SOFTWARE.

The clock input to the timer can be from an external source (decrementing of Timer Counter occurs on a positive transition of the external source) applied to the TIMER input pin or it can be the internal $\phi 2$ signal. When the $\phi 2$ signal is used as the source, it can be gated by an input applied to the TIMER input pin allowing the user to easily perform pulsewidth measurements. (Note: For ungated $\phi 2$ clock inputs to the timer prescaler, the TIMER pin should be tied to VCC).

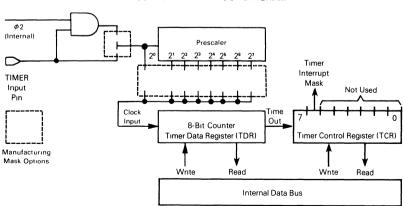


FIGURE 9 — TIMER BLOCK DIAGRAM

The source of the clock input is one of the mask options that is specified before manufacture of the MCU

A prescaler option can be applied to the clock input that extends the timing interval up to a maximum of 128 counts before decrementing the counter. This prescaling mask option is also specified before manufacture.

The timer continues to count past zero, falling through to \$FF from zero and then continuing the count. Thus, the counter can be read at any time by reading the Timer Data Register (TDR). This allows a program to determine the length of time since a timer interrupt has occurred, and not disturb the counting process.

At Power-up or Reset, the prescaler and counter are initialized with all logical ones, the timer interrupt request bit (bit 7) is cleared, and the timer interrupt mask bit (bit 6) is set

SELF-CHECK

The self-check capability of the MC6805P2 MCU provides an internal check to determine if the part is functional. Connect the MCU as shown in Figure 10 and monitor the output of Port C bit 3 for an oscillation of approximately 7 Hz. A 9 volt level on the Timer input, Pin 7, energizes the ROMbased self-check feature. The self-check program exercises the RAM, ROM, timer, interrupts, and I/O ports.

RESETS

The MCU can be reset three ways by initial power-up, by the external reset input (RESET), and by an optional internal low voltage detect circuit, see Figure 11. The internal circuit connected to the RESET pin consists of a Schmitt trigger which senses the RESET line logic level. The Schmitt trigger provides an internal reset voltage if it senses a logic 0 on the RESET pin. During power-up, the Schmitt trigger switches on (removes reset) when the RESET pin voltage rises to VIRES +. When the RESET pin voltage falls to a logical 0 for a period longer than one $t_{\rm CyC}$, the Schmitt trigger switches off to provide an internal reset voltage. The "switch off" voltage occurs at VIRES —. A typical reset Schmitt trigger hysteresis curve is shown in Figure 12.

Upon power-up, a delay of tRHL is needed before allowing the RESET input to go high. This time allows the internal clock generator to stabilize. Connecting a capacitor to the RESET input as shown in Figure 13, typically provides sufficient delay. See Figure 17 for the complete reset sequence.

INTERNAL CLOCK GENERATOR OPTIONS

The internal clock generator circuit is designed to require a minimum of external components. A crystal, a resistor, a jumper wire, or an external signal may be used to generate a system clock with various stability/cost tradeoffs. A

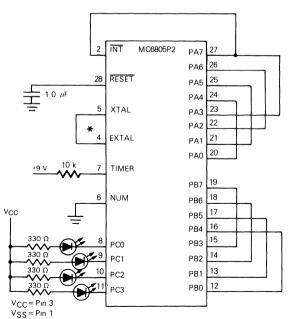


FIGURE 10 - SELF-CHECK CONNECTIONS

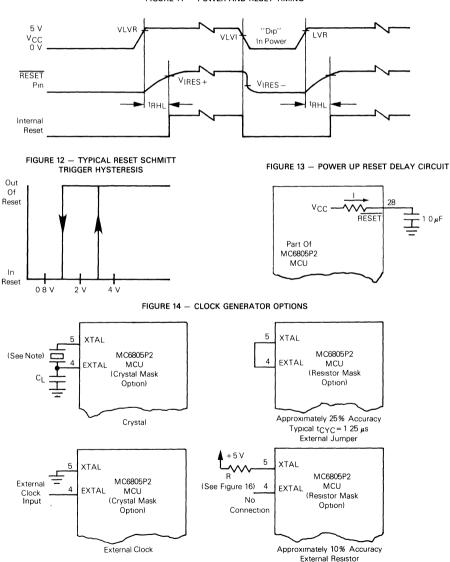
^{*}This connection depends on the clock oscillator user selectable mask option. Use crystal if that option is selected.

manufacturing mask option is required to select either the crystal oscillator or the RC oscillator circuit. The oscillator frequency is internally divided by four to produce the internal system clocks.

The different connection methods are shown in Figure 14. The crystal specifications are given in Figure 15. A resistor selection graph is given in Figure 16.

The crystal oscillator startup time is a function of many variables crystal parameters (especially Rs), oscillator load capacitance, IC parameters, ambient temperature, and supply voltage. To ensure rapid oscillator startup, neither the crystal characteristics nor the load capacitance should exceed recommendations.

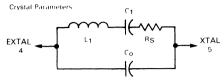
FIGURE 11 - POWER AND RESET TIMING



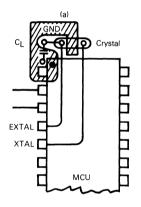
(Excludes Resistor Tolerance)

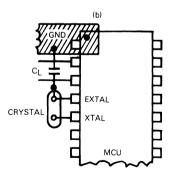
NOTE The recommended C_L value with a 4 0 MHz crystal is 27 pF, maximum, including system distributed capacitance. There is an internal capacitance of approximately 25 pF on the XTAL pin. For crystal frequencies other than 4 MHz, the total capacitance on each pin should be scalled as the inverse of the frequency ratio. For example, with a 2 MHz crystal, use approximately 50 pF on EXTAL and approximately 25 pF on XTAL. The exact value depends on the Motional-Arm parameters of the crystal used.

FIGURE 15 — CRYSTAL MOTIONAL ARM PARAMETERS AND SUGGESTED PC BOARD LAYOUT



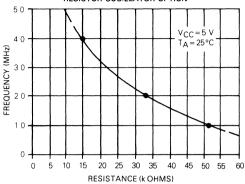
AT — Cut Parallel Resonance Crystal $C_0 = 7$ pF Max FREQ = 4 0 MHz @ $C_L = 24$ pF $R_S = 50$ ohms Max





Note Keep crystal leads and circuit connections as short as possible

FIGURE 16 — TYPICAL FREQUENCY SELECTION FOR RESISTOR OSCILLATOR OPTION



INTERRUPTS

The MC6805P2 MCU can be interrupted three different ways through the external interrupt ($\overline{\text{INT}}$) input pin, the internal timer interrupt request, or the software interrupt instruction (SWI) When any interrupt occurs, processing is suspended, the present CPU state is pushed onto the stack, the interrupt bit (I) in the condition code register is set, the address of the interrupt routine is obtained from the appropriate interrupt vector address, and the interrupt routine is executed Stacking the CPU register, setting the l-bit, and vector fetching requires a total of 11 t_{CVC} periods for completion

A flowchart of the interrupt sequence is shown in Figure 17. The interrupt service routine must end with a return from interrupt (RTI) instruction which allows the MCU to resume processing of the program prior to the interrupt (by unstacking the previous CPU state). Table 1 provides a listing of the interrupts, their priority, and the address of the vector which contains the starting address of the appropriate interrupt service routine. The interrupt priority applies to those pending when the CPU is ready to accept a new interrupt RESET is listed in Table 1 because it is treated as an interrupt. However, it is not normally used as an interrupt. When the interrupt mask bit in the Condition Code Register is set the interrupt is latched for later interrupt execution.

The external interrupt is internally synchronized and then latched on the falling edge of INT. A sinusoidal input signal ($f_{|NT|}$ maximum) can be used to generate an external interrupt, as shown in Figure 18a, for use as a Zero Crossing Detector. For digital applications the $\overline{|NT|}$ can be driven by a digital signal at a maximum period of $t_{|NT|}$. This allows applications such as servicing time-of-day routines and engaging/disengaging AC power control devices. Off-chip full wave rectification provides an interrupt at every zero crossing of the AC signal and thereby provides a 2f clock.

A software interrupt (SWI) is an executable instruction which is executed regardless of the state of the I-bit in the Condition Code Register—SWI's are usually used as breakpoints for debugging or as system calls

Set 1 Bit Reset 1→I (in CCR) 07F— SP Clear 0-DDR's Stack ĪNT PC, X, A, CC CLR INT Logic Edge Request FF → Timer Latch 7 F→Prescaler 7F→TCR N $1 \rightarrow 1$ CR 6=0 Timer And TCR 7= Load PC From Put on 7FE 7FC/7FD SWI Address Bus INT 7FA / 7FB N 7F8 / 7F9 Timer Fetch Instruction Reset RESET Pin = Low RESET SWI SWI PC←PC+1 Pin = High Load PC from 7FE/7FF Execute Instruction

FIGURE 17 - RESET AND INTERRUPT PROCESSING FLOWCHART

FIGURE 18 - TYPICAL INTERRUPT CIRCUITS

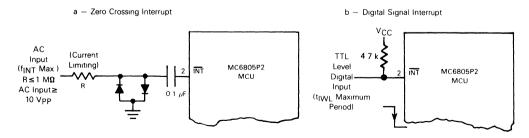


TABLE 1 - INTERRUPT PRIORITIES

| Interrupt | Priority | Vector Address |
|-----------|----------|-----------------|
| RESET | 1 | \$7FE and \$7FF |
| SWI | 2* | \$7FC and \$7FD |
| INT | 3 | \$7FA and \$7FB |
| Timer | 4 | \$7F8 and \$7F9 |

*Priority 2 applies when the I-bit in the Condition Code Register is set When I = 0, SWI has a priority of 4, like any other instruction, the priority of INT thus becomes 2 and the timer becomes 3

INPUT/OUTPUT

There are 20 input/output pins. The $\overline{\text{INT}}$ pin may also be pulled with branch instructions to provide an additional input pin All pins (Port A, B, and C) are programmable as either inputs or outputs under software control of the corresponding Data Direction Register (DDR). The port I/O programming is accomplished by writing the corresponding bit in the port DDR to a logic ''1" for output or a logic ''0" for input. On Reset, all the DDRs are initialized to a logic ''0" state to put the ports in the input mode. The port output registers are not initialized on Reset but may be written to before setting the DDR bits to avoid undefined levels. When programmed as outputs, the latched output data is readable as input data, regardless of the logic levels at the output pin due to output loading, see Figure 19. When Port B is pro-

grammed for outputs, it is capable of sinking 10 mA and sourcing a 1 mA on each pin

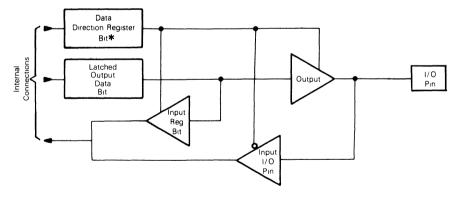
All input/output lines are TTL compatible as both inputs and outputs. Ports B and C are CMOS compatible as inputs. Port A may be made CMOS compatible as outputs with a mask option. The address map in Figure 6 gives the address of data registers and DDRs. The register configuration is provided in Figure 20 and Figure 21 provides some examples of port connections.

Caution

The corresponding DDRs for ports A, B, and C are write-only registers (registers at \$004, \$005, and \$006) A read operation on these registers is undefined. Since BSET and BCLR are read/modify/write functions, they cannot be used to set or clear a DDR bit (all "unaffected" bits would be set) It is recommended that all DDR bits in a port be written using a single store instruction

The latched output data bit (see Figure 19) may always be written. Therefore, any write to a port writes all of its data bits even though the port DDR is set to input. This may be used to initialize the data registers and avoid undefined outputs, however, care must be exercised when using read/modify/write instructions since the data read corresponds to the pin level of the DDR is an input (0) and corresponds to the latched output data when the DDR is an output (1)

FIGURE 19 - TYPICAL PORT I/O CIRCUITRY

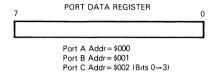


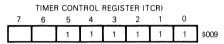
| Data Direction Register Bit | Output Data Bit | Output State | Input To MCU |
|--------------------------------------|-----------------------|-----------------|--------------------|
| 1 | 0 | 0 | 0 |
| 1 | 1 | 1 | 1 |
| 0 |) × | 3-State** | Pın |

^{*}DDR is a write-only register and reads as all 1's

^{**}Ports A (with CMOS drive disabled), B, and C are three state ports. Port A has optional internal pullup devices to provide CMOS drive capability. See Electrical Characteristics tables for complete information.

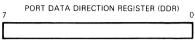
FIGURE 20 - MCU REGISTER CONFIGURATION





TCR7 – Timer Interrupt Status Bit Set when TDR goes to zero, must be cleared by software Cleared to 0 by Reset

TCR6 Bit 6—Timer Interrupt Mask Bit 1 = timer interrupt masked (disabled) Set to 1 by Reset TCR Bits 5, 4, 3, 2, 1, 0 read 1's—unused bits



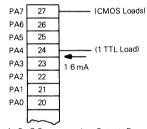
- (1) Write Only, reads as all 1's
- (2) 1 = Output, 0 = Input Cleared to 0 by Reset
- (3) Port A Addr = \$004 Port B Addr = \$005 Port C Addr = \$006 (Bits 0→3)

TIMER DATA REGISTER (TDR)

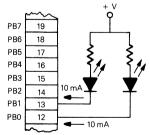
| 7 | (|) |
|-----|-----|-------|
| MSB | LSB | \$008 |

FIGURE 21 - TYPICAL PORT CONNECTIONS

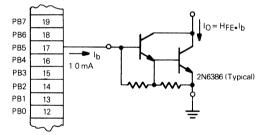
a. Output Modes



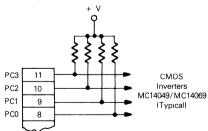
Port A, Bit 7 Programmed as Output, Driving CMOS Loads and Bit 4 Driving one TTL Load Directly (using CMOS output option)



Port B, Bit 0 and Bit 1 Programmed as Output, Driving LEDs Directly



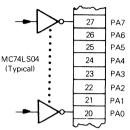
Port B, Bit 5 Programmed as Output, Driving Darlington-Base Directly



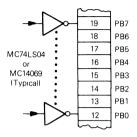
Port C, Bits 0-3 Programmed as Output, Driving CMOS Loads, Using External Pullup Resistors

FIGURE 21 - TYPICAL PORT CONNECTIONS (CONTINUED)

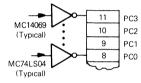
b. Input Modes



TTL Driving Port A Directly



CMOS or TTL Driving Port B Directly



CMOS and TTL Driving Port C Directly

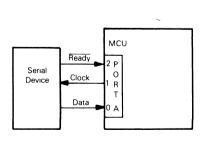
BIT MANIPULATION

The MC6805P2 MCU has the ability to set or clear any . single random access memory or input/output bit (except the Data Direction Register, see Caution under INPUT/OUT-PUT paragraph), with a single instruction (BSET, BCLR) Any bit in page zero including ROM, except the DDRs, can be tested, using the BRSET and BRCLR instructions, and the program branches as a result of its state. The Carry bit equals the value of the bit referenced by BRSET or BRCLR A Rotate instruction may then be used to accumulate serial input data in a RAM location or register. The capability to work with any bit in RAM, ROM, or I/O allows the user to

have individual flags in RAM or to handle I/O bits as control

The coding example in Figure 22 illustrates the usefulness of the bit manipulation and test instructions. Assume that the MCU is to communicate with an external serial device The external device has a data ready signal, a data output line, and a clock line to clock data one bit at a time, LBS first, out of the device. The MCU waits until the data is ready, clocks the external device, picks up the data in the Carry Flag (C-bit), clears the clock line, and finally accumulates the data bit in a RAM location

FIGURE 22 - BIT MANIPULATION EXAMPLE



BRSET 2, PORTA, SELF SELF BSET 1, PORTA BRCLR O, PORTA, CONT CONT BCLR 1, PORTA ASR RAMLOC

ADDRESSING MODES

The MC6805P2 MCU has 10 addressing modes which are explained briefly in the following paragraphs. For additional details and graphical illustrations, refer to the M6805 Family Liser's Manual.

The term "effective address" (EA) is used in describing the address modes EA is defined as the address from which the argument for an instruction is fectived or stored

IMMEDIATE — In the immediate addressing mode, the operand is contained in the byte immediately following the opcode. The immediate addressing mode is used to access constants which do not change during program execution (e.g., a constant used to initialize a loop counter).

DIRECT — In the direct addressing mode, the effective address of the argument is contained in a single byte following the opcode byte Direct addressing allows the user to directly address the lowest 256 bytes in memory with a single 2-byte instruction. This includes the on-chip RAM and I/O registers and 128 bytes of ROM. Direct addressing is an effective use of both memory and time.

EXTENDED — In the extended addressing mode, the effective address of the argument is contained in the two bytes following the opcode Instructions using extended addressing are capable of referencing arguments anywhere in memory with a single 3-byte instruction. When using the Motorola assembler, the programmer need not specify whether an instruction uses direct or extended addressing. The assembler automatically selects the shortest form of the instruction.

RELATIVE — The relative addressing mode is only used in branch instructions. In relative addressing, the contents of the 8-bit signed byte following the opcode (the offset) is added to the PC if and only if the branch condition is true. Otherwise, control proceeds to the next instruction. The span of relative addressing is from —126 to +129 from the opcode address. The programmer need not worry about calculating the correct offset when using the Motorola assembler, since it calculates the proper offset and checks to see if it is within the span of the branch.

INDEXED, NO OFFSET — In the indexed, no offset addressing mode, the effective address of the argument is contained in the 8-bit index register. Thus, this addressing mode can access the first 256 memory locations. These instructions are only one byte long. This mode is often used to move a pointer through a table or to hold the address of a frequently referenced RAM or I/O location.

INDEXED, 8-BIT OFFSET — In the indexed, 8-bit offset addressing mode, the effective address is the sum of the contents of the unsigned 8-bit index register and the unsigned byte following the opcode. This addressing mode is useful in selecting the kth element in an nielement table. With this 2-byte instruction, k would typically be in X with the address of the beginning of the table in the instruction. As such tables may begin anywhere within the first 256 addressable locations and could extend as far as location 511 (51FF).

INDEXED, 16-BIT OFFSET — In the indexed, 16-bit offset addressing mode, the effective address is the sum of the contents of the unsigned 8-bit index register and the two unsigned bytes following the opcode. This addressing mode can be used in a manner similar to indexed, 8-bit offset, except that this 3-byte instruction allows tables to be anywhere in memory.

BIT SET/CLEAR — In the bit set/clear addressing mode, the bit to be set or cleared is part of the opcode, and the byte following the opcode specifies the address of the byte in which the specified bit is to be set direct or cleared. Thus, any read/write bit in the first 256 locations of memory, including I/O, can be selectively set or cleared with a single 2-byte instruction. See Caution under the INPUT/OUTPUT paragraph.

BIT TEST AND BRANCH — The bit test and branch addressing mode is a combination of direct addressing and relative addressing. The bit and condition (set or clear) which is to be tested is included in the opcode, and the address of the byte to be tested is in the single byte immediately following the opcode byte. The signed relative 8-bit offset is in the third byte and is added to the value of the PC if the branch condition is true. This single 3-byte instruction allows the program to branch based on the condition of any readable bit in the first 256 locations of memory. The span of branching is from + 130 to - 125 from the opcode address. The state of the tested bit is also transferred to the Carry bit of the Condition. Code. Register. See Caution under the INPUT/OUTPUT paragraph.

INHERENT — In the inherent addressing mode, all the information necessary to execute the instruction is contained in the opcode. Operations specifying only the index register or accumulator, as well as control instruction with no other arguments, are included in this mode. These instructions are one byte long.

INSTRUCTION SET

The MC6805P2 MCU has a set of 59 basic instructions, which when combined with the 10 addressing modes produce 207 usable opcodes. They can be divided into five different types register/memory, read/modify/write, branch, bit manipulation, and control. The following paragraphs briefly explain each type. All the instructions within a given type are presented in individual tables.

REGISTER/MEMORY INSTRUCTIONS — Most of these instructions use two operands. One operand is either the accumulator or the index register. The other operand is obtained from memory using one of the addressing modes. The jump unconditional (JMP) and jump to subroutine (JSR) instructions have no register operands. Refer to Table 2.

READ/MODIFY/WRITE INSTRUCTIONS — These instructions read a memory location or a register, modify or test its contents, and write the modified value back to memory or to the register (see Caution under INPUT/OUT-PUT paragraph) The test for negative or zero (TST) instruction is included in read/modify/write instructions though it does not perform the write Refer to Table 3

BRANCH INSTRUCTIONS — The branch instructions cause a branch from the program when a certain condition is met. Refer to Table 4

BIT MANIPULATION INSTRUCTIONS — These instructions are used on any bit in the first 256 bytes of the memory (see Caution under INPUT/OUTPUT paragraph). One group either sets or clears. The other group performs the bit test branch operations. Refer to Table 5.

CONTROL INSTRUCTIONS — The control instructions control the MCU operations during program execution Refer to Table 6

ALPHABETICAL LISTING — The complete instruction set is given in alphabetical order in Table 7

 $\ensuremath{\mathsf{OPCODE}}$ $\ensuremath{\mathsf{MAP}}$ $\ensuremath{\mathsf{SUMMARY}}$ — Table 8 is an opcode map for the instructions used on the MCU

TABLE 2 - REGISTER/MEMORY INSTRUCTIONS

| | | | | | | | | | А | ddressin | g Mode | es | | | | | | | |
|---|----------|------------|------------|-------------|------------|------------|-------------|------------|---------------------|-------------|------------|---------------------------|-------------|------------|----------------------------|-------------|------------|------------|-------------|
| | | | lmmed | ıate | Direct | | | | Indexed (No Offset) | | | Indexed (8-Bit Offset) | | | Indexed (16-Bit Offset) | | | | |
| Function | Mnemonic | Op Code | # Bytes | # Cycles | Op Code | # Bytes | # Cycles | Op Code | # Bytes | # Cycles | Op Code | # Bytes | # Cycles | Op Code | # Bytes | # Cycles | OP Code | # Bytes | # Cycles |
| Load A from Memory | LDA | A6 | 2 | 2 | В6 | 2 | 4 | C6 | 3 | 5 | F6 | 1 | 4 | E6 | 2 | 5 | D6 | 3 | 6 |
| Load X from Memory | LDX | AE | 2 | 2 | BE | 2 | 4 | CE | 3 | 5 | FE | 1 | 4 | EE | 2 | 5 | DE | 3 | 6 |
| Store A in Memory | STA | - | - | _ | В7 | 2 | 5 | C7 | 3 | 6 | F7 | 1 | 5 | E7 | 2 | 6 | D7 | 3 | 7 |
| Store X in Memory | STX | _ | _ | - | BF | 2 | 5 | CF | 3 | 6 | FF | 1 | 5 | EF | 2 | 6 | DF | 3 | 7 |
| Add Memory to A | ADD | AB | 2 | 2 | BB | 2 | 4 | CB | 3 | 5 | FB | 1 | 4 | EB | 2 | 5 | DB | 3 | 6 |
| Add Memory and Carry to A | ADC | A9 | 2 | 2 | В9 | 2 | 4 | C9 | 3 | 5 | F9 | 1 | 4 | E9 | 2 | 5 | D9 | 3 | 6 |
| Subtract Memory | SUB | A0 | 2 | 2 | во | 2 | 4 | CO | 3 | 5 | FO | 1 | 4 | EO | 2 | 5 | D0 | 3 | 6 |
| Subtract Memory from A with Borrow | SBC | A2 | 2 | 2 | В2 | 2 | 4 | C2 | 3 | 5 | F2 | 1 | 4 | E2 | 2 | 5 | D2 | 3 | 6 |
| AND Memory to A | AND | Α4 | 2 | 2 | В4 | 2 | 4 | C4 | 3 | 5 | F4 | 1 | 4 | E4 | 2 | 5 | D4 | 3 | 6 |
| OR Memory with A | ORA | AA | 2 | 2 | BA | 2 | 4 | CA | 3 | 5 | FA | 1 | 4 | EA | 2 | 5 | DA | 3 | 6 |
| Exclusive OR Memory with A | EOR | A8 | 2 | 2 | В8 | 2 | 4 | С8 | 3 | 5 | F8 | 1 | 4 | E8 | 2 | 5 | D8 | 3 | 6 |
| Arithmetic Compare A with Memory | СМР | Α1 | 2 | 2 | В1 | 2 | 4 | C1 | 3 | 5 | F1 | 1 | 4 | E1 | 2 | 5 | D1 | 3 | 6 |
| Arithmetic Compare X with Memory | СРХ | А3 | 2 | 2 | В3 | 2 | 4 | С3 | 3 | 5 | F3 | 1 | 4 | E3 | 2 | 5 | D3 | 3 | 6 |
| Bit Test Memory with A (Logical Compare) | ВІТ | A5 | 2 | 2 | В5 | 2 | 4 | C5 | 3 | 5 | F5 | 1 | 4 | E5 | 2 | 5 | D5 | 3 | 6 |
| Jump Unconditional | JMP | _ | - | | BC | 2 | 3 | CC | 3 | 4 | FC | 1 | 3 | EC | 2 | 4 | DC | 3 | 5 |
| Jump to Subroutine | JSR | _ | _ | - | BD | 2 | 7 | CD | 3 | 8 | FD | 1 | 7 | ED | 2 | 8 | DD | 3 | 9 |

TABLE 3 - READ/MODIFY/WRITE INSTRUCTIONS

| | | | Addressing Modes | | | | | | | | | | | | | |
|------------------------------|----------|------------|---------------------------|-------------|------------|------------|-------------|------------|------------|-------------|------------|------------|---------------------------|------------|------------|-------------|
| | | 11 | Inherent (A) Inherent (X) | | | t (X) | Direct | | | (| Index | | Indexed (8 Bit Offset) | | | |
| Function | Mnemonic | Op Code | # Bytes | # Cycles | Op Code | # Bytes | # Cycles | Op Code | # Bytes | # Cycles | Op Code | # Bytes | # Cycles | Op Code | # Bytes | # Cycles |
| Increment | INC | 4C | 1 | 4 | 5C | 1 | 4 | 3C | 2 | 6 | 7C | 1 | 6 | 6C | 2 | 7 |
| Decrement | DEC | 4A | 1 | 4 | 5A | 1 | 4 | 3A | 2 | 6 | 7A | 1 | 6 | 6A | 2 | 7 |
| Clear | CLR | 4F | 1 | 4 | 5F | 1 | 4 | 3F | 2 | 6 | 7F | 1 | 6 | 6F | 2 | 7 |
| Complement | сом | 43 | 1 | 4 | 53 | 1 | 4 | 33 | 2 | 6 | 73 | 1 | 6 | 63 | 2 | 7 |
| Negate (2's Complement) | NEG | 40 | 1 | 4 | 50 | 1 | 4 | 30 | 2 | 6 | 70 | 1 | 6 | 60 | 2 | 7 |
| Rotate Left Thru Carry | ROL | 49 | 1 | 4 | 59 | 1 | 4 | 39 | 2 | 6 | 79 | 1 | 6 | 69 | 2 | 7 |
| Rotate Right Thru Carry | ROR | 46 | 1 | 4 | 56 | 1 | 4 | 36 | 2 | 6 | 76 | 1 | 6 | 66 | 2 | 7 |
| Logical Shift Left | LSL | 48 | 1 | 4 | 58 | 1 | 4 | 38 | 2 | 6 | 78 | 1 | 6 | 68 | 2 | 7 |
| Logical Shift Right | LSR | 44 | 1 | 4. | 54 | 1 | 4 | 34 | 2 | 6 | 74 | 1 | 6 | 64 | 2 | 7 |
| Arithmetic Shift Right | ASR | 47 | 1 | 4 | 57 | 1 | 4 | 37 | 2 | 6 | 77 | 1 | 6 | 67 | 2 | 7 |
| Test for Negative or Zero | TST | 4D | 1 | 4 | 5D | 1 | 4 | 3D | 2 | 6 | 7D | 1 | 6 | 6D | 2 | 7 |

TABLE 4 — BRANCH INSTRUCTIONS

| | | Relative | Addressi | ng Mode |
|--|----------|----------|----------|---------|
| | | Ор | # | # |
| Function | Mnemonic | Code | Bytes | Cycles |
| Branch Always | BRA | 20 | 2 | 4 |
| Branch Never | BRN | 21 | 2 | 4 |
| Branch IFF Higher | ВНІ | 22 | 2 | 4 |
| Branch IFF Lower or Same | BLS | 23 | 2 | 4 |
| Branch IFF Carry Clear | всс | 24 | 2 | 4 |
| (BranchIFFHigher or Same) | (BHS) | 24 | 2 | 4 |
| Branch IFF Carry Set | BCS | 25 | 2 | 4 |
| (Branch/FF Lower) | (BLO) | 25 | 2 | 4 |
| Branch IFF Not Equal | BNE | 26 | 2 | 4 |
| Branch IFF Equal | BEQ | 27 | 2 | 4 |
| Branch Half Carry Clear | внсс | 28 | 2 | 4 |
| Branch IFF Half Carry Set | BHCS | 29 | 2 | 4 |
| Branch (FF Plus | BPL | 2A | 2 | 4 |
| BranchIFF Minus | ВМІ | 2B | 2 | 4 |
| Branch IFF Interupt Mask Bit is Clear | вмс | 2C | 2 | 4 |
| BranchIFFInterrupt Mask Bit is Set | BMS | 2D | 2 | 4 |
| Branch IFF Interrupt Line is Low | BIL | 2E | 2 | 4 |
| Branch IFF Interrupt Line is High | ВІН | 2F | 2 | 4 |
| Branch to Subroutine | BSR | AD | 2 | 8 |

TABLE 5 — BIT MANIPULATION INSTRUCTIONS

| | | Addressing Modes | | | | | | | | |
|---------------------------|-------------------|------------------|------------|-------------|---------------------|------------|-------------|--|--|--|
| | | Bit | Set/Cl | lear | Bit Test and Branch | | | | | |
| Function | Mnemonic | Op Code | # Bytes | # Cycles | Op Code | # Bytes | # Cycles | | | |
| Branch IFF Bit n is set | BRSET n (n = 0 7) | _ | _ | _ | 2 • n | 3 | 10 | | | |
| Branch IFF Bit n is clear | BRCLR n (n = 0 7) | _ | | _ | 01 + 2 • n | 3 | 10 | | | |
| Set Bit n | BSET n (n = 0 7) | 10 + 2 • n | 2 | 7 | _ | _ | _ | | | |
| Clear bit n | BCLR n (n = 0 7) | 11 + 2 • n | 2 | 7 | _ | _ | _ | | | |

TABLE 6 - CONTROL INSTRUCTIONS

| | | Inherent | | | | | | | |
|--------------------------|----------|----------|-------|--------|--|--|--|--|--|
| | | Op | # | # | | | | | |
| Function | Mnemonic | Code | Bytes | Cycles | | | | | |
| Transfer A to X | TAX | 97 | 1 | 2 | | | | | |
| Transfer X to A | TXA | 9F | 1 | 2 | | | | | |
| Set Carry Bit | SEC | 99 | 1 | 2 | | | | | |
| Clear Carry Bit | CLC | 98 | 1 | 2 | | | | | |
| Set Interrupt Mask Bit | SEI | 9B | 1 | 2 | | | | | |
| Clear Interrupt Mask Bit | CLI | 9A | 1 | 2 | | | | | |
| Software Interrupt | SWI | 83 | 1 | 11 | | | | | |
| Return from Subroutine | RTS | 81 | 1 | 6 | | | | | |
| Return from Interrupt | RTI | 80 | 1 | 9 | | | | | |
| Reset Stack Pointer | RSP | 9C | 1 | 2 | | | | | |
| No-Operation | NOP | 9D | 1 | 2 | | | | | |

TABLE 7 - INSTRUCTION SET

| | ſ | | | A | ddressing | Modes | | | | | Co | nd | itio | n C | ode |
|----------|--|--|----------|---|--|--|--|--|--|--|----|----|----------------|----------------|--|
| Mnemonic | Inherent | Immediate | Direct | Extended | Relative | Indexed (No Offset) | | Indexed | | Bit Test & Branch | н | | N | z | С |
| ADC | | X | X | × | | X | × | X | | | ٨ | • | ^ | 1 | ٨ |
| ADD | | × | X | X | | × | × | × | | | ^ | • | ٨ | ^ | ٨ |
| AND | | × | × | × | | × | × | X | - | | • | • | ^ | ٨ | • |
| ASL | × | | X | | | × | X | | | | • | • | ٨ | ^ | ٨ |
| ASR | X | | X | | <u> </u> | × | X | | | | • | • | ^ | ^ | ^ |
| BCC | | | | <u> </u> | X | | | | - | | • | • | • | • | • |
| BCLR | | | | | | | | | X | | • | • | • | • | • |
| BCS | <u> </u> | | | | × | | | | | | • | • | • | • | • |
| BEQ | | | | <u> </u> | × | | † | | l | | • | • | • | • | • |
| внсс | | | | <u> </u> | × | | | | | | • | • | • | • | • |
| BHCS | | + | | | X | | | | | | • | • | • | • | • |
| ВНІ | | | | | X | 1 | | <u> </u> | | | • | • | • | • | • |
| BHS | | | | | × | 1 | | | | | • | • | • | • | • |
| BIH | - | | | | X | | | | | | • | • | • | • | • |
| BIL | | t | | <u> </u> | × | | | | | | • | • | • | • | • |
| BIT | | × | X | X | | X | X | × | | | • | • | ٨ | ٨ | • |
| BLO | | | | | X | | | | | | • | • | • | • | • |
| BLS | | | | | × | | | | | | • | • | • | • | • |
| BMC | | | | | X | | | | | | • | • | • | • | • |
| BMI | | | | | | | | | | | • | • | • | • | • |
| BMS | | - | | | | | | | | | • | • | • | • | • |
| BNE | | | | | | | | ┼ | | | • | • | • | +- | • |
| BPL | | | | | ļ — — — — | | | | ├ | | • | - | • | • | |
| BRA | | | | | | - | | | ├ | | • | • | • | • | • |
| BRN | | | | | | - | | | | | • | • | • | • | • |
| BRCLR | | | | ļ | ļ | | | | | × | • | • | • | • | ^ |
| BRSET | | | | | | | | ļ | | X | • | • | • | • | \ \ \ |
| BSET | | | | | | | | | × | <u> </u> | • | • | • | • | • |
| BSR | | | | | X | | | | `` - | | • | • | • | • | • |
| CLL | × | | | | | | | | | | • | • | • | • | 0 |
| CLI | X | - | | | | | | | | | • | 0 | • | • | • |
| CLR | X | | X | | | X | X | | ├ | | • | • | 0 | 1 | • |
| CMP | ^ - | × | × | X | | X | X | X | | | • | • | 7 | <u>,</u> | ^ |
| COM | X | | X | ^ _ | | | X | ^ | | | • | • | 1 | <u> </u> | 1 |
| CPX | ^ | × | X | X | - | X | X | X | ├ | | • | • | \ \ | \ <u>\</u> | <u> </u> |
| DEC | X | ~~ | X | <u> </u> | | X | X | <u> </u> | ├ | | • | • | 1 | 1 | 1 A |
| EOR | ^ - | X | × | x | | X | $\frac{\hat{x}}{x}$ | × | ├ | | • | • | \ \ | \ | • |
| INC | × | `` | X | ` | | x x | ^ | +-~- | | | • | • | \ \ | \ \ | • |
| JMP | ^ _ | | × | X | | | \\ \x | x | | | - | • | • | • | • |
| JSR | | | × | \ | | \ x | × | + ^ | | | • | • | • | • | • |
| LDA | | × | × | × | | ^ | × | + ^ | | | - | - | _ | <u></u> | - |
| LDX | | ^ | × | X | | X | × | ^ | ├ | | • | • | \ <u>\</u> | ^ | • |
| LSL | × | | X | | | $\frac{\lambda}{x}$ | × | +-^- | | | • | - | \ \ | ^ | 1 |
| LSR | × | | × | | | ^ | x | + | ├ | | • | - | 6 | <u>\</u> | ^ |
| NEQ | × | | × | | + | X | l ^ | + | ├ ── | | - | • | 7 | \ \ | 1 |
| NOP | + ^ | | <u> </u> | - | | ^ | ^ | + | ├ | | • | - | • | <u> </u> | • |
| ORA | ^ - | × | × | × | | X | X | × | | | • | • | ^ | <u></u> | • |
| ROL | × | ^ - | × | ^ _ | | X | ^ | +-^- | ├ | | - | - | ^ | ^ | ^ |
| RSP | × | | <u> </u> | | | ^ | ^ - | + | } | ├ | - | • | • | 6 | 1 |
| nor | _ ^ | 1 | l | | 1 | ii | 1 | 1 | 1 | 1 | | Ľ | _ | | |

Condition Code Symbols

- Z Zero

- Note Course Symbols

 H Half Carry (From Bit 3)
 I Interrupt Mask
 N Negative (Sign Bit)

 C Carry/Borrow
 A Test and Set if True, Cleared Otherwise
 Not Affected

TABLE 7 - INSTRUCTION SET (CONTINUED)

| | | | | A | ddressing | Modes | | | | Č | nd | itio | n C | ode |
|----------|----------|-----------|--------|----------|-----------|------------------------|---|----------------------|-------------------------|---|----|------|-----|-----|
| Mnemonic | Inherent | Immediate | Direct | Extended | Relative | Indexed (No Offset) | | Indexed (16 Bits) | Bit Test & Branch | н | | N | z | С |
| RTI | X | | | | | | | | | ? | ? | ? | ? | ? |
| RTS | Х | | | | | | | | | • | • | • | • | • |
| SBC | | × | Х | Х | | × | Х | Х | | • | • | ٨ | Λ | ٨ |
| SEC | Х | | | | | | | | | • | • | • | • | 1 |
| SEI | х | | | | | | | | | • | 1 | • | • | • |
| STA | | | Х | X | | × | X | X | | • | • | ٨ | Λ | • |
| STX | | | Х | X | | × | × | X | | • | • | Λ | Λ | • |
| SUB | | X | Х | Х | | × | X | Х | | • | • | Λ | ٨ | Λ |
| SWI | Х | | | | | | | | | • | 1 | • | • | • |
| TAX | X | | | | | | | | | • | • | • | • | • |
| TST | × | | X | | | X | X | | | • | • | Λ | ٨ | • |
| TXA | Х | | | | | | | | | • | • | • | • | • |

Condition Code Symbols

- H Half Carry (From Bit 3)
- I Interrupt Mask
- N Negative (Sign Bit)
 Z Zero

- C Carry/Borrow
- A Test and Set if True, Cleared Otherwise
- Not Affected
- ? Load CC Register From Stack

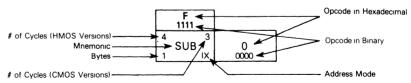
TABLE 8 - M6805 FAMILY OPCODE MAP

| | Bit Mar | nipulation | Branch | T | Re | ad/Modify/\ | Vrite | | Con | trol | | | Registe | r/Memory | | | |
|-----------|-------------------------|----------------------------|----------------------|---------------------|----------------------|----------------------|---------------------|--------------------|-----------------------|---------------------|-----------------------|---------------------|-----------------------|---------------------|-----------------------|--------------------|-----------|
| | BTB | BSC | REL | DIR | INH(A) | INH(X) | IX1 | IX | INH | INH | IMM | DIR | EXT | IX2 | IX1 | IX F | 1 |
| Low | 0000 | 1 0001 | 2 0010 | 3 0011 | 4 0100 | 5 0101 | 6 0110 | 7 0111 | 1000 | 9 1001 | 1010 | B 1011 | C 1100 | D 1101 | E 1110 | J111 | Hi |
| 0000 | BRSETO 3 BTB | BSET0 2 BSC | BRA 2 REL | 6 5 NEG 2 DIR | 4 NEGA 1 INH | 4 NEGX 1 INH | 7 6 NEG 2 IX1 | 6 NEG 5 | RTI 1 INH | | SUB 2 1MM | SUB DIR | SUB 3 EXT | SUB 3 IX2 | SUB 2 IX1 | SUB 3 | 0000 |
| 1 0001 | BRCLRO 3 BTB | 7 BCLR0 2 BSC | BRN 2 REL | | | | | | 6 6 RTS 1 INH | | CMP 2 1MM | CMP 2 DIR | 5 4 CMP 3 EXT | CMP 3 IX2 | CMP 2 IX1 | 4 CMP IX | 1 0001 |
| 2 0010 | BRSET1 3 BTB | BSET1 2 BSC | BHI 2 REL | | | | | | | | SBC 2 | SBC 3 2 DIR | SBC 3 EXT | SBC IX2 | SBC 2 IX1 | SBC 1 | 2 0010 |
| 3 0011 | BRCLR1 3 BTB | 7 BCLR1 2 BSC | BLS REL | 6 COM 2 DIR | COMA 1 INH | COMX 1 INH | 7 COM 6 | 6 COM 5 | 11 10 SWI 1 INH | | CPX 2 1MM | CPX DIR | CPX 3 EXT | 6 CPX 3 IX2 | CPX 2 IX1 | 4 CPX 1 1X 1X 3 | 3 0011 |
| 4 0100 | BRSET2 3 BTB | BSET2 BSC | BCC REL | 6 LSR 2 DIR | LSRA | 4 LSRX 1 INH | LSR 2 IX1 | LSR | | | 2 AND 2 2 1MM 2 2 | AND DIR | 5 AND 3 EXT 5 4 | AND 3 IX2 | AND 2 IX1 | AND IX | 4 0100 |
| 5 0101 | BRCLR2 3 BTB | BCLR2 | BCS REL | 6 5 | 4 3 | 4 3 | 7 6 | 6 5 | | | BIT 2 2 IMM 2 2 | BIT DIR | BIT SEXT | BIT 3 | BIT 2 IX1 | BIT IX | 5 0101 |
| 6 0110 | BRSET3 3 BTB | BSET3 2 BSC 7 | BNE REL | ROR 2 DIR 6 5 | RORA 1 INH 4 3 | RORX 1 INH | ROR 2 IX1 | ROR IX | | 2 2 | LDA 2 | LDA 2 DIR 5 4 | LDA 3 EXT | 3 LDA 3 | LDA 2 IX1 | LDA 1 IX | 6 0110 |
| 7 0111 | BRCLR3 3 BTB | BCLR3 2 BSC 7 5 | BEQ 2 REL | ASR 2 DIR 6 5 | ASRA 1 INH | ASRX 1 INH | ASR 2 IX1 | ASR 1 1X 6 5 | | TAX 1 INH 2 2 | 2 2 | STA 2 DIR | STA 3 EXT | STA 3 IX2 6 5 | STA 2 IX1 | STA 1 IX 4 3 | 7 0111 |
| 1000 | BRSET4 3 BTB | BSET4 2 BSC | BHCC 2 REL 4 3 | 191 | LSLA 1 INH | LSLX 1 INH | LSL 2 IX1 | LSL 1 IX | | CLC 1 INH 2 2 | EOR 2 IMM | EOR | EOR 3 EXT | EOR 3 IX2 | EOR IX1 | EOR 1X | 8 1000 |
| 9 1001 | BRCLR4 3 BTB | BCLR4 2 BSC 7 5 | 2 REL | ROL 2 DIR 6 5 | ROLA 1 INH | ROLX 1 INH | ROL 2 IX1 | ROL IX | | SEC 1 INH 2 2 | ADC 2 IMM | ADC 2 DIR 3 | ADC 3 EXT | ADC 3 1X2 6 5 | ADC 2 IX1 5 4 | ADC 1X | 9 1001 |
| A 1010 | BRSET5 3 BTB 10 5 | BSET5 2 BSC 7 5 | BPL 2 REL 4 3 | DEC 2 DIR | DECA 1 INH | DECX 1 INH | DEC 2 IX1 | DEC IX | | CLI 1 INH 2 2 | ORA 2 IMM 2 2 | ORA 2 DIR 4 3 | ORA 3 EXT 5 4 | ORA 3 IX2 6 5 | ORA 2 IX1 5 4 | ORA 1 IX 4 3 | A 1010 |
| B 1011 | BRCLR5 3 BTB 10 5 | BCLR5 2 BSC 7 5 | | 6 5 | | 4 3 | | | | SEI 1 INH 2 2 | ADD 2 IMM | 3 2 | ADD 3 EXT 4 3 | ADD 3 IX2 5 4 | ADD 2 IX1 4 3 | ADD 1X 3 2 | B 1011 |
| C 1100 | BRSET6 3 BTB 10 5 | BSET6 2 BSC 7 5 | BMC 2 REL 4 3 | INC 2 DIR 6 4 | INCA 1 INH 4 3 | INCX 1 INH 4 3 | | INC 1 IX 6 4 | | RSP 1 INH 2 2 | | 7 5 | | JMP 3 IX2 9 7 | JMP 2 IX1 8 6 | JMP 1 IX 7 5 | C 1100 |
| D 1101 | BRCLR6 3 BTB 10 5 | BCLR6 2 BSC 7 5 | BMS 2 REL 4 3 | TST 2 DIR | TSTA 1 INH | TSTX 1 INH | TST 2 IX1 | TST 1 IX | 2 | NOP 1 INH | BSR 2 REL 2 2 | JSR 2 DIR 4 3 | | JSR 3 IX2 6 5 | | JSR 1 IX 4 3 | D 1101 |
| 1110 | BRSET7 3 BTB | BSET7 2 BSC 7 DOLD 7 | BIL 2 REL 4 3 | 6 5 | 4 3 | 4 3 | | 6 5 | STOP 1 INH | 2 2 | LDX 2 IMM | LDX DIR 5 4 | LDX 3 EXT 6 STV | 3 IX2 | LDX 2 X1 6 5 | | E 1110 |
| F 1111 | BRCLR7 3 BTB | BCLR7 2 BSC | DIFI | i CLn | CLRA 1 INH | CLRX 1 INH | CLR 2 IX1 | CLR 1 IX | WAIT 1 INH | TXA 1 INH | | STX 2 DIR | STX 3 EXT | STX 3 IX2 | STX 2 IX1 | 1 STX | 1111 |

Abbreviations for Address Modes

INH Inherent IMM Immediate DIR Direct EXT Extended REL Relative BSC Bit Set/Clear BTB Bit Test and Branch IX Indexed (No Offset) IX1 Indexed, 1 Byte (8-Bit) Offset IX2 Indexed, 2 Byte (16-Bit) Offset **CMOS Versions Only**

LEGEND

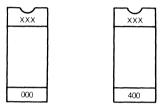


ORDERING INFORMATION

The information required when ordering a custom MCU is listed below. The ROM program may be transmitted to Motorola on EPROM(s) or a MDOS disk file.

To initiate a ROM pattern for the MCU it is necessary to first contact your local Motorola representative or Motorola distributor

EPROMs — The MCM2716 or MCM2532 type EPROMs, programmed with the customer program (positive logic sense for address and data), may be submitted for pattern generation. The EPROM must be clearly marked to indicate which EPROM corresponds to which address space. The recommended marking procedure is illustrated below.



XXX = Customer ID

After the EPROM(s) are marked they should be placed in conductive IC carriers and securely packed. Do not use styrofoam

VERIFICATION MEDIA

All original pattern media (EPROMs or Floppy Disk) are filed for contractual purposes and are not returned A computer listing of the ROM code will be generated and returned along with a listing verification form. The listing should be thoroughly checked and the verification form completed,

signed, and returned to Motorola. The signed verification form constitutes the contractual agreement for creation of the customer mask. If desired, Motorola will program on blank EPROM from the data file used to create the custom mask and aid in the verification process.

ROM VERIFICATION UNITS (RVUs)

Ten MCUs containing the customer's ROM pattern will be sent for program verification. These units will have been made using the custom mask but are for the purpose of ROM verification only. For expediency they are usually unmarked, packaged in ceramic, and tested only at room temperature and 5 volts. These RVUs are included in the mask charge and are not production parts. The RVUs are thus not guaranteed by Motorola Quality Assurance, and should be discarded after verification is completed.

FLEXIBLE DISKS

The disk media submitted must be single-sided, single-density, 8-inch, MDOS compatible floppies. The customer must write the binary file name and company name on the disk with a felt-tip pen. The minimum MDOS system files as well as the absolute binary object file (filename L0 type of file) from the M6805 cross assembler must be on the disk. An object file made from a memory dump using the ROLLOUT command is also acceptable. Consider submitting a source listing as well as the following files filename, LX (EXOR-ciser® loadable format) and filename, SA (ASCII Source Code). These files will of course be kept confidential and are used 1) to speed up the process in-house if any problems arise, and 2) to speed up the user-to-factor interface if the user finds any software errors and needs assistance quickly from Motorola factory representatives.

MDOS is Motorola's Disk Operating system available on development systems such as EXORcisers, EXORsets, etc.

MC6805P2 MCU ORDERING INFORMATION

| Customer Company | | | |
|---|-----------------------|---------------------|---|
| Address | | | MC |
| City | State | | SC |
| Country | | | |
| Phone | Extension | | |
| Customer Contact Person | | | |
| Customer Part Number | | | |
| OPTION LIST Select the options manufacturing mask | | | |
| Timer Clock Source □ Internal ¢2 clock □ TIMER input pin | | | |
| Timer Prescaler 2º (divide by 1) 2¹ (divide by 2) 2² (divide by 4) 2³ (divide by 8) | | ☐ 2 ⁵ (d | ivide by 16) ivide by 32) ivide by 64) ivide by 128) |
| Internal Oscillator Input Crystal Resistor | | Port A Outpo | S and TTL |
| Low Voltage Inhibit ☐ Disable ☐ Enable | | | |
| Pattern Media (All other media requires p | rior factory approval |) | |
| ☐ EPROMs (MCM2716 o | or MCM2532 | | oppy Disk her |
| Clock Freq | | | |
| Temp Range | | (Standard) | ∃ −40° to +85°C * |
| *Requires prior factory approval | | | |
| Marking Information (12 Characters Maximum) | | | |
| | | | |
| | | | |



MC6805P4

Advance Information

8-BIT MICROCOMPUTER UNIT

The MC6805P4 Microcomputer Unit (MCU) is a member of the M6805 Family of low-cost single-chip microcomputers. This 8-bit microcomputer contains a CPU, on-chip CLOCK, ROM, RAM, I/O, and TIMER. It is designed for the user who needs an economical microcomputer with the proven capabilities of the M6800-based instruction set. A comparison of the key features of several members of the M6805 Family is shown on the last page of this data sheet. The following are some of the hardware and software highlights of the MC6805P4 MCU.

HARDWARE FEATURES:

- 8-Bit Architecture
- 112 Bytes of Standby RAM
- Standby RAM Power Pin
- Memory Mapped I/O
- 1100 Bytes of User ROM
- 20 TTL/CMOS Compatible Bidirectional I/O Lines (8 Lines are LED Compatible)
- On-Chip Clock Generator
- Self-Check Mode
- Zero Crossing Detection
- Master Reset
- Complete Development System Support on EXORciser®
- 5 V Single Supply

SOFTWARE FEATURES:

- Similar to M6800 Family
- Byte Efficient Instruction Set
- Easy to Program
- True Bit Manipulation
- Bit Test and Branch Instructions
- Versatile Interrupt Handling
- Versatile Index Register
- Powerful Indexed Addressing for Tables
- Full Set of Conditional Branches
- Memory Usable as Register/Flags
- Single Instruction Memory Examine/Change
- 10 Powerful Addressing Modes
- All Addressing Modes Apply to ROM, RAM, and I/O

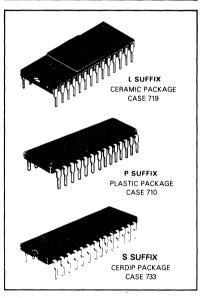
USER SELECTABLE OPTIONS:

- Internal 8-Bit Timer with Selectable Clock Source (External Timer Input or Internal Machine Clock)
- Timer Prescaler Option (7 Bits 2N)
- 8 Bidirectional I/O Lines with TTL or TTL/CMOS Interface Option
- Crystal or Low-Cost Resistor Oscillator Option
- Low Voltage Inhibit Option
- 4 Vectored Interrupts, Timer, Software, and 2 External

HMOS

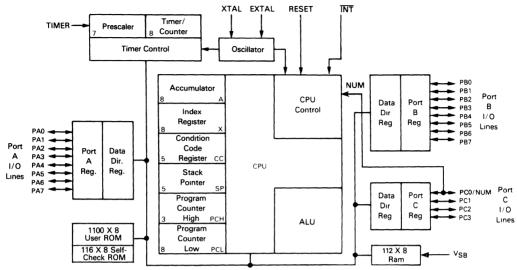
(HIGH DENSITY N-CHANNEL, SILICON-GATE -DEPLETION LOAD)

8-BIT MICROCOMPUTER



| FIGURE | 1 — PIN ASS | IGNMENTS |
|---|---------------------------------|--|
| VSS [INT [VCC [EXTAL [XTAL [TIMER [PCO/NUM [PC1 [PC2 [PC3 [PB0 [PB1 [| 1 2 3 4 5 6 6 7 8 9 10 11 12 13 | 28] RESET 27] PA7 26] PA6 25] PA5 24] PA4 23] PA3 22] PA2 21] PA1 20] PA0 19] PB7 18] PB6 17] PB5 16] PB4 |
| PB2 [| | 15 PB3 |

FIGURE 2 - MC6805P4 HMOS MICROCOMPUTER BLOCK DIAGRAM



MAXIMUM RATINGS

| Rating | Symbol | Value | Unit |
|--------------------------------|------------------|----------------|------|
| Supply Voltage | Vcc | -03 to +70 | V |
| Input Voltage (Except PCO/NUM) | V _{in} | -0.3 to +7.0 | V |
| Operating Temperature Range | TA | 0 to 70 | °C |
| Storage Temperature Range | T _{stg} | -55 to +150 | °C |
| Junction Temperature | | | |
| Plastic | Ì | 150 | ĺ |
| Ceramic | TJ | 175 | °C |
| Cerdip | | 175 | |

This device contains circuitry to protect the inputs against damage due to high static voltages or electrical fields, however, it is advised that normal precautions be taken to avoid application of any voltage higher than maximum rated voltages to this high-impedance circuit. For proper operation it is recommended that V_{1n} and V_{out} be constrained to the range $V_{SS}\!\leq\!(V_{in}$ or $V_{out})\!\leq\!V_{CC}$. Reliability of operation is enchanced if unused inputs except EXTAL are tied to an appropriate logic voltage level (e.g., either V_{SS} or V_{CC}).

THERMAL CHARACTERISTICS

| Characteristic | Symbol | Value | Unit |
|---|--------|-----------------|------|
| Thermal Resistance Plastic Ceramic Cerdip | θΔΑ | 120 50 60 | °C/W |

POWER CONSIDERATIONS

The average chip-junction temperature, TJ, in °C can be obtained from

$$T_{J} = T_{A} + (P_{D} \bullet \theta_{JA})$$
Where:
(1)

T_A = Ambient Temperature, °C

θJA = Package Thermal Resistance, Junction-to-Ambient, °C/W

PD=PINT+PPORT

PINT=ICC × VCC, Watts - Chip Internal Power

PPORT = Port Power Dissipation, Watts - User Determined

For most applications PPORT ≪ PINT and can be neglected. PPORT may become significant if the device is configured to drive Darlington bases or sink LED loads.

An approximate relationship between PD and TJ (if PPORT is neglected) is:

$$P_D = K + (T_1 + 273 ^{\circ}C)$$
 (2)

Solving equations 1 and 2 for K gives:

$$K = PD \bullet (TA + 273 \circ C) + \theta JA \bullet PD^2$$
(3)

Where K is a constant pertaining to the particular part. K can be determined from equation 3 by measuring PD (at equilibrium) for a known TA. Using this value of K the values of PD and TJ can be obtained by solving equations (1) and (2) iteratively for any value of TA.

$\textbf{SWITCHING CHARACTERISTICS} \ (\textit{V}_{CC} = +5.25 \ \textit{Vdc} \ \pm 0.5 \ \textit{Vdc}, \ \textit{V}_{SS} = \textit{GND}, \ \textit{T}_{A} = 0 \ \textrm{o} \ \textrm{to} \ 50 \ \textrm{o} \ \textrm{unless otherwise noted})$

| Characteristic | Symbol | Mın | Тур | Max | Unit |
|--|------------------|------------------------|-----|-----|------|
| Oscillator Frequency | fosc | 0.4 | - | 4 2 | MHz |
| Cycle Time (4/f _{osc}) | tcyc | 0 95 | | 10 | μS |
| INT and TIMER Pulse Width | tWL,tWH | t _{CyC} + 250 | | _ | ns |
| RESET Pulse Width | ^t RWL | t _{cyc} + 250 | - | | ns |
| \overline{RESET} Delay Time (External Capacitance = 1 0 μ F) | †RHL | - | 100 | - | ms |
| INT Zero Crossing Detection Input Frequency (±5° Accuracy) | fINT | 0 03 | _ | 10 | kHz |
| External Clock Input Duty Cycle (EXTAL) | _ | 40 | 50 | 60 | % |

$\textbf{ELECTRICAL CHARACTERISTICS} \quad (V_{CC} = +5.25 \; \text{Vdc} \pm 0.5 \; \text{Vdc}, \; V_{SS} = \text{GND}, \; T_{A} = 0^{\circ} \; \text{to} \; 70^{\circ}\text{C} \; \text{unless otherwise noted})$

| Characteristic | Symbol | Mın | Тур | Max | Unit |
|---|-------------------|---------------------|-----|------|----------------------|
| Input High Voltage | | | | | |
| RESET (4 75≤V _{CC} ≤5 75) | | 40 | - | Vcc | |
| (V _{CC} <4 75) | } | V _{CC} −05 | - | Vcc | |
| INT (4 75≤V _{CC} ≤5 75) | VIH | 40 | * | Vcc | V |
| (V _{CC} <4 75) | | V _{CC} -05 | * | Vcc | |
| All Other | | 20 | _ | Vcc | |
| Input High Voltage Timer | | | | | |
| Timer Mode | l v _{iH} | 20 | - | Vcc | V |
| Self-Check Mode | <u> </u> | - | 90 | 15 0 | |
| Input Low Voltage | | | | | |
| RESET |] | -03 | - | 0.8 | |
| INT | VIL | -03 | * | 15 | V |
| All Other | | -03 | | 0.8 | |
| RESET Hysteresis Voltage (See Figures 11, 12, and 13) | | | | | |
| "Out of Reset" | VIRES+ | 21 | _ | 4 G | V |
| "Into Reset" | VIRES- | 0.8 | - | 20 | |
| INT Zero Crossing Input Voltage, Through a Capacitor | VINT | 20 | - | 40 | V _{a-c p-p} |
| Internal Power Dissipation – No Port Loading V _{CC} =5 75 V, T _A =0°C | PINT | _ | 400 | TBD | mW |
| Input Capacitance | | | | | |
| EXTAL | C _{in} | - | 25 | - | ρF |
| All Other | | _ | 10 | _ | |
| Low Voltage Recover | V _{LVR} | - | - | 4 75 | V |
| Low Voltage Inhibit | VLVI | - | 3 5 | - | ٧ |
| Input Current | | | | | |
| TIMER (V _{ID} = 0 4 V) | | - | _ | 20 | |
| INT (V _{ID} = 2.4 V to V _{CC} , Crystal Option) | | - | 20 | 50 | |
| EXTAL (V _{In} = 0 4 V, Crystal Option) | I _{In} | | - | 10 | μΑ |
| $(V_{in} = 0.4 V)$ | | - | | 1600 | |
| RESET (V _{ID} = 0 8 V) | 1 | -40 | - | -50 | |
| (External Capacitor Charging Current) | | | | | |

^{*}Due to internal biasing, this input (when unused) floats to approximately 2 0 Vdc

PORT DC ELECTRICAL CHARACTERISTICS ($V_{CC} = +5.25 \text{ Vdc} \pm 0.5 \text{ Vdc}$, $V_{SS} = \text{GND}$, $T_A = 0^{\circ}$ to 70°C unless otherwise noted)

| Characteristic | Symbol | Min | Тур | Max | Unit |
|--|--------------------------|-----|-----|-------|------|
| Port A with | CMOS Drive Enabled | | | | |
| Output Low Voltage, I _{Load} = 1 6 mA | V _{OL} | | _ | 0 4 | V |
| Output High Voltage, $I_{Load} = -100 \mu A$ | VOH | 2 4 | _ | _ | V |
| Output High Voltage, I _{Load} = -10 μA | Voн | 3 5 | - | - | V |
| Input High Voltage, I _{Load} = -300 μA (max) | VIH | 20 | - | Vcc | V |
| Input Low Voltate, I _{Load} = -500 µA (max) | V _{IL} | -30 | - | 0.8 | ٧ |
| Hi-Z State Input Current (V _{In} =20 V to V _{CC}) | \l | _ | _ | -300 | μΑ |
| Hi-Z State Input Current (V _{IN} = 0 4 V) | li L | _ | _ | - 500 | μΑ |
| | Port B | | | | |
| Output Low Voltage, ILoad=32 mA | V _{OL} | - | | 04 | ٧ |
| Output Low Voltage, I _{Load} = 10 mA (sink) | V _{OL} | | _ | 10 | V |
| Output High Voltage, ILoad = -200 µA | Voн | 2 4 | _ | - | V |
| Darlington Current Drive (Source), V _O = 1 5 V | 10Н | -10 | _ | - 10 | mA |
| Input High Voltage | VIH | 20 | _ | Vcc | V |
| Input Low Voltage | V _{IL} | -03 | _ | 0.8 | V |
| Hi-Z State Input Current | ^I TSI | _ | 2 | 20 | μΑ |
| Port C and Port A | with CMOS Drive Disabled | | | | |
| Output Low Voltage, ILoad = 1 6 mA | V _{OL} | - | - | 04 | V |
| Output High Voltage, ILoad = -100 µA | Voн | 2 4 | _ | _ | V |
| Input High Voltage | VIH | 20 | _ | Vcc | V |
| Input Low Voltage | V _{IL} | -03 | - | 0.8 | V |
| Hi-Z State Input Current | ^I TSI | - | 2 | 20 | μΑ |

STANDBY RAM CHARACTERISTICS (Temperature = 0° C, $V_{SB} = Max$)

| Characteristic | Symbol | Min | Тур | Max | Unit |
|-------------------------------|-------------------|-----|------|-------|------|
| Standby Current | | | | | |
| 16 Bytes | | i – | 16 | TBD | İ |
| 64 Bytes | I _{SB} | - | 3 4 | TBD | μΑ |
| 112 Bytes | | - | 5 2 | TBD | |
| RAM Standby Voltage | V _{SB} | TBD | 5 25 | TBD | ٧ |
| V _{CC} Turn-off Rate | V _{ССТО} | _ | _ | 1/100 | V/μs |

FIGURE 3 — TTL EQUIVALENT TEST LOAD FIGURE 4 — CMOS EQUIVALENT TEST LOAD (PORT A)

Test MMD6150 $V_{CC} = 5.75 \text{ V}$ Point or Equiv $1.5 \text{ k}\Omega$ 40 pF $1.25 \text{ k}\Omega$ MMD7000 or Equiv C = 40 pF (Total)

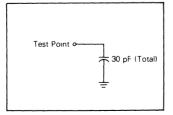
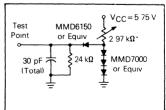


FIGURE 5 — TTL EQUIVALENT TEST LOAD
(PORTS A AND C)



SIGNAL DESCRIPTION

The input and output signals for the MCU, shown in Figure 1, are described in the following paragraphs

 $\mbox{VSB},\mbox{VCC},\mbox{VSS}$ — Power is supplied to the MCU using these two pins \mbox{VCC} is power and \mbox{VSS} is the ground connection

VSB is the standby RAM voltage. In order to allow orderly transition into the standby mode, the turn-off rate of VCC must not exceed 1 volt per 100 ns

 $\overline{\text{INT}}$ — This pin provides the capability for asynchronously applying an external interrupt to the MCU Refer to INTER-RUPTS for additional information

XTAL AND EXTAL — These pins provide connections to the on-chip clock oscillator circuit. A crystal, a resistor, or an external signal depending on the user selectable manufacturing mask option, can be connected to these pins to provide a system clock source with various stability/cost tradeoff beautiful to the pins and stray capacitance on these two pins should be minimized. Refer to INTERNAL CLOCK GENERATOR OPTIONS for recommendations about these inputs.

TIMER — This pin allows an external input to be used to decrement the internal timer circuitry. Refer to TIMER for additional information about the timer circuitry.

RESET — This pin allows resetting of the MCU at times other than the automatic resetting capability already in the MCU Refer to RESETS for additional information

 $\mathbf{NUM}-\mathbf{This}$ pin is not for user application and must be connected to \mathbf{VSS}

INPUT/OUTPUT LINES (A0-A7, B0-B7, C0-C3) — These 20 lines are arranged into two 8-bit ports (A and B) and one 4-bit port (C). All lines are programmable as either inputs or outputs under software control of the data direction registers. Refer to INPUTS/OUTPUTS for additional information.

MEMORY

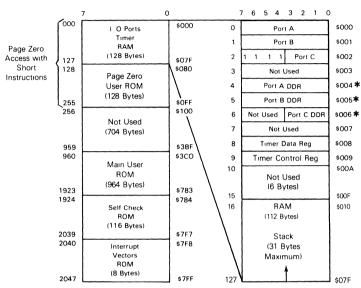
As shown in Figure 6, the MCU is capable of addressing 2048 bytes of memory and I/O registers with its program counter. The MC6805P4 MCU has implemented 1336 of these locations. This consists of 1100 bytes of user ROM, 116 bytes of self-check ROM, 112 bytes of user RAM, 6 bytes of port I/O, and 2 timer registers.

The stack area is used during the processing of interrupt and subroutine calls to save the processor state. The register contents are pushed onto the stack in the order shown in Figure 7. Because the stack pointer decrements during pushes, the low order byte (PCL) of the program counter is stacked first, then the high order three bits (PCH) are stacked. This ensures that the program counter is loaded correctly, during pulls from the stack, since the stack pointer increments during pulls. A subroutine call results in only the program counter (PCL, PCH) contents being pushed onto the stack. The remaining CPU registers are not pushed.

CENTRAL PROCESSING UNIT

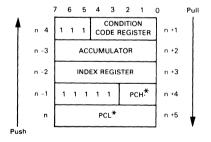
The CPU of the M6805 Family is inplemented independently from the I/O or memory configuration Consequently, it can be treated as an independent central processor communication with I/O and memory via internal address, data, and control buses

FIGURE 6 - MC6805P4 MCU ADDRESS MAP



^{*}Caution (DDRs) are write-only, they read as \$FF

FIGURE 7 - INTERRUPT STACKING ORDER



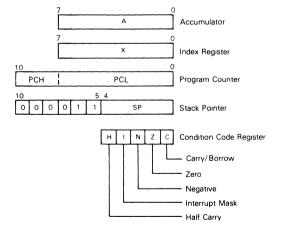
^{*}For subroutine calls, only PCL and PCH are stacked

REGISTERS

The M6805 Family CPU has five registers available to the programmer. They are shown in Figure 8 and are explained in the following paragraphs.

ACCUMULATOR (A) — The accumulator is a general purpose 8-bit register used to hold operands and results of arithmetic calculations or data manipulations.

FIGURE 8 -- PROGRAMMING MODEL



INDEX REGISTER (X) — The index register is an 8-bit register used for the indexed addressing mode. It contains an 8-bit value that may be added to an instruction value to create an effective address. The index register can also be used for data manipulations using the read/modify/write instructions. The index register may also be used as a temporary storage area.

PROGRAM COUNTER (PC) — The program counter is an 11-bit register that contains the address of the next instruction to be executed

STACK POINTER (SP) — The stack pointer is an 11-bit register that contains the address of the next free location on the stack. Initially, the stack pointer is set to location \$07F and is decremented as data is being pushed onto the stack and incremented as data is being pulled from the stack. The six most significant bits of the stack pointer are permanently set to 000011. During a MCU reset or the Reset Stack Pointer (RSP) instruction, the stack pointer is set to location \$07F. Subroutines and interrupts may be nested down to location \$061 (31 bytes maximum) which allows the programmer to use up to 31 levels of subroutine calls.

CONDITION CODE REGISTER (CC) — The condition code register is a 5-bit register in which four bits are used to indicate the results of the instruction just executed. These bits can be individually tested by a program and specific action taken as a result of their state. Each individual condition code register bit is explained in the following paragraphs.

 $\mbox{ Half Carry (H)} - \mbox{ Set during ADD and ADC instructions to indicate that a carry occurred between bits 3 and 4}$

Interrupt (I) — This bit is set to mask (disable) the timer and external interrupt (INT). If an interrupt occurs while this

bit is set the interrupt is latched and is processed as soon as the interrupt bit is cleared

Negative (N) — Used to indicate that the result of the last arithmetic, logical or data manipulation was negative (bit 7 in result equal to a logical one)

Zero (Z) — Used to indicate that the result of the last arithmetic, logical or data manipulation was zero

Carry/Borrow (C) — Used to indicate that a carry or borrow out of the arithmetic logic unit (ALU) occurred during the last arithmetic operation. This bit is also affected during bit test and branch instructions plus shifts and rotates

TIMER

The MC6805P4 MCU timer circuitry is shown in Figure 9. The 8-bit counter may be loaded under program control and is decremented toward zero by the clock input (prescaler output). When the timer reaches zero, the timer interrupt request bit (bit 7) in the Timer Control Register (TCR) is set. The timer interrupt can be masked (disabled) by setting the timer interrupt mask bit (bit 6) in the TCR. The interrupt bit (II-bit) in the Condition Code Register also prevents a timer interrupt from being processed. The MCU responds to this interrupt by saving the present CPU state in the stack, fetching the timer interrupt vector from locations \$7F8 and \$7F9 and executing the interrupt routine, see the INTER-RUPTS section. The TIMER INTERRUPT REQUEST BIT MUST BE CLEARED BY SOFTWARE.

The clock input to the timer can be from an external source (decrementing of Timer Counter occurs on a positive transition of the external source) applied to the TIMER input pin or it can be internal $\phi 2$ signal. When the $\phi 2$ signal is used as the source, it can be gated by an input applied to the TIMER input pin allowing the user to easily perform pulsewidth measurements. (Note for ungated $\phi 2$ clock inputs to the timer prescaler, the TIMER pin should be tied to C_{CC} .)

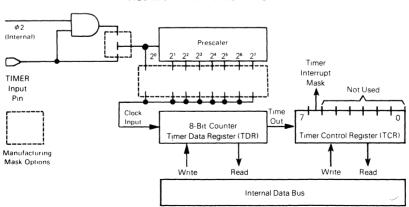


FIGURE 9 - TIMER BLOCK DIAGRAM

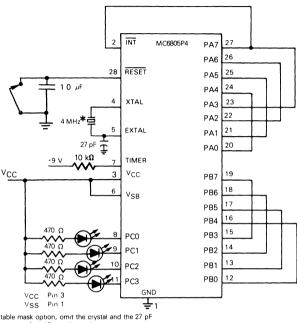


FIGURE 10 - SELF-CHECK CONNECTIONS

* NOTE For RC user selectable mask option, omit the crystal and the 27 pF capacitor and connect pin 4 and 5 together with a jumper

The source of the clock input is one of the mask options that is specified before manufacture of the MCU

A prescaler option, divided by 2^{n} , can be applied to the clock input that extends the timing interval up to a maximum of 128 counts before decrementing the counter. This prescaling mask option is also specified before manufacture

The timer continues to count past zero, falling through to \$FF from zero and then continuing the count. Thus, the counter can be read at any time by reading the Timer Data Register (TDR). This allows a program to determine the length of time since a timer interrupt has occurred, and not disturb the counting process.

At Power-up or Reset, the prescaler and counter areinitialized with all logical ones, the timer interrupt request bit (bit 7) is cleared, and the timer interrupt mask bit (bit 6) is set

SELF-CHECK

The self-check capability of the MC6805P4 MCU provides an internal check to determine if the part is functional. Connect the MCU as shown in Figure 10 and monitor the output of Port C bit 3 for an oscillation of approximately 7 Hz. A 9 volt level on the TIMER input, Pin 7, energizes the ROM-based self-check feature. The self-check program exercises the RAM, ROM, timer, interrupts, and I/O ports.

RESETS

The MCU can be reset three ways by initial power-up, by the external reset input (RESET), and by an optional internal low voltage detect circuit, see Figure 11. The internal circuit connected to the RESET pin consists of a Schmitt trigger which senses the RESET line logic level. The Schmitt trigger provides an internal reset voltage if it senses a logic 0 on the RESET pin During power-up, the Schmitt trigger switches on (removes reset) when the RESET pin voltage rises to VIRES+. When the RESET pin voltage falls to a logical 0 for a period longer than one toyo, the Schmitt trigger switches off to provide an internal reset voltage. The "switch off" voltage occurs at VIRES-. A typical reset Schmitt trigger invisteresis curve is shown in Figure 12.

Upon power-up, a delay of t_{RHL} is needed before allowing the RESET input to go high. This time allows the internal clock generator to stabilize. Connecting a capacitor to the RESET input as shown in Figure 13, typically provides sufficient delay. See Figure 17 for the complete reset sequence.

INTERNAL CLOCK GENERATOR OPTIONS

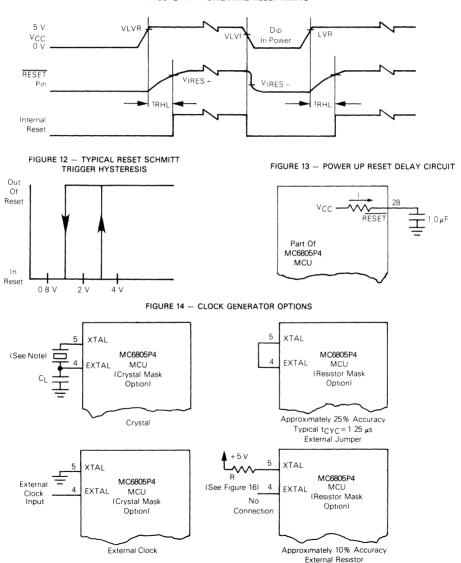
The internal clock generator circuit is designed to require a minimum of external components. A crystal, a resistor, a jumper wire, or an external signal may be used to generate a system clock with various stability/cost tradeoffs. A

manufacturing mask option is required to select either the crystal oscillator or the RC oscillator circuit. The oscillator frequency is internally divided by four to produce the internal system clocks.

The different connection methods are shown in Figure 14. The crystal specifications are given in Figure 15. A resistor selection graph is given in Figure 16.

The crystal oscillator startup time is a function of many variables crystal parameters (especially Rs), oscillator load capacitance, IC parameters, ambient temperature, and supply voltage. To ensure rapid oscillator startup, neither the crystal characteristics nor the load capacitance should exceed recommendations.

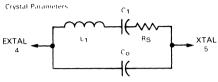
FIGURE 11 - POWER AND RESET TIMING



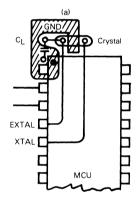
(Excludes Resistor Tolerance)

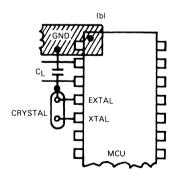
NOTE The recommended C_L value with a 4 0 MHz crystal is 27 pF, maximum, including system distributed capacitance. There is an internal capacitance of approximately 25 pF on the XTAL pin. For crystal frequencies other than 4 MHz, the total capacitance on each pin should be scalled as the inverse of the frequency ratio. For example, with a 2 MHz crystal, use approximately 50 pF on EXTAL and approximately 25 pF on XTAL. The exact value depends on the Motional-Arm parameters of the crystal used.

FIGURE 15 — CRYSTAL MOTIONAL ARM PARAMETERS AND SUGGESTED PC BOARD LAYOUT



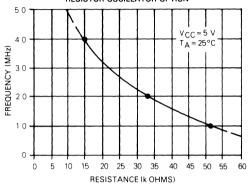
AT — Cut Parallel Resonance Crystal C_0 = 7 pF Max FREQ = 4 0 MHz @ C_L = 24 pF R_S = 50 ohms Max





Note. Keep crystal leads and circuit connections as short as possible

FIGURE 16 — TYPICAL FREQUENCY SELECTION FOR RESISTOR OSCILLATOR OPTION



INTERRUPTS

The MC6805P2 MCU can be interrupted three different ways through the external interrupt ($\overline{\text{INT}}$) input pin, the internal timer interrupt request, or the software interrupt instruction (SWI) When any interrupt occurs, processing is suspended, the present CPU state is pushed onto the stack, the interrupt bit (I) in the condition code register is set, the address of the interrupt routine is obtained from the appropriate interrupt vector address, and the interrupt routine is executed. Stacking the CPU register, setting the l-bit, and vector fetching requires a total of 11 t_{CVC} periods for completion

A flowchart of the interrupt sequence is shown in Figure 17. The interrupt service routine must end with a return from interrupt (RTI) instruction which allows the MCU to resume processing of the program prior to the interrupt (by unstacking the previous CPU state). Table 1 provides a listing of the interrupts, their priority, and the address of the vector which contains the starting address of the appropriate interrupt service routine. The interrupt priority applies to those pending when the CPU is ready to accept a new interrupt. RESET is listed in Table 1 because it is treated as an interrupt. However, it is not normally used as an interrupt. When the interrupt mask bit in the Condition Code Register is set the interrupt is latched for later interrupt execution.

The external interrupt is internally synchronized and then latched on the falling edge of $\overline{\text{INT}}$ A sinusoidal input signal (fint maximum) can be used to generate an external interrupt, as shown in Figure 18a, for use as a Zero Crossing Detector For digital applications the $\overline{\text{INT}}$ can be driven by a digital signal at a maximum period of tiwl. This allows applications such as servicing time-of-day routines and engaging/disengaging AC power control devices Off-chip full wave rectification provides an interrupt at every zero crossing of the AC signal and thereby provides a 2f clock

A software interrupt (SWI) is an executable instruction which is executed regardless of the state of the I-bit in the Condition Code Register—SWI's are usually used as breakpoints for debugging or as system calls

I Bit Reset Clear 1→I (in CCR) 07F— SP 0→DDR's Clear Stack INT ĪNT PC, X, A, CC CLR INT Logic Edge Request Latch FF → Timer 7 F→Prescaler 7F→TCR Ν CR 6=0 Timer And TCR 7= Load PC From Put on 7FE SWI 7FC/7FD Address Bus 7FA / 7FB INT N Timer 7F8 / 7F9 Fetch Instruction Reset RESET Pin = Low RESET SWI SWI PC←PC+1 Pın ≈ Hıgh Load PC from 7FE/7FF Execute Instruction

FIGURE 17 - RESET AND INTERRUPT PROCESSING FLOWCHART

FIGURE 18 - TYPICAL INTERRUPT CIRCUITS

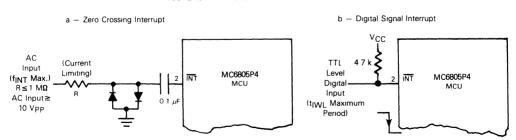


TABLE 1 - INTERRUPT PRIORITIES

| Interrupt | Priority | Vector Address |
|-----------|----------|-----------------|
| RESET | 1 1 | \$7FE and \$7FF |
| SWI | 2* | \$7FC and \$7FD |
| INT | 3 | \$7FA and \$7FB |
| Timer | 4 | \$7F8 and \$7F9 |

^{*}Priority 2 applies when the I-bit in the Condition Code Register is set When I=0, SWI has a priority of 4, like any other instruction, the priority of INT thus becomes 2 and the timer becomes 3

INPUT/OUTPUT

There are 20 input/output pins. The $\overline{\text{INT}}$ pin may also be pulled with branch instructions to provide an additional input pin. All pins (Port A, B, and C) are programmable as either inputs or outputs under software control of the corresponding Data Direction Register (DDR). The port I/O programming is accomplished by writing the corresponding bit in the port DDR to a logic ''1" for output or a logic ''0" for input. On Reset, all the DDRs are initialized to a logic ''0" state to put the ports in the input mode. The port output registers are not initialized on Reset but may be written to before setting the DDR bits to avoid undefined levels. When programmed as outputs, the latched output data is readable as input data, regardless of the logic levels at the output pin due to output loading, see Figure 19. When Port B is pro-

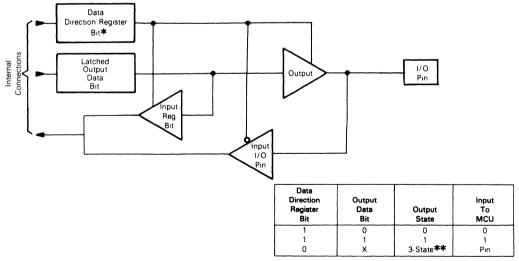
grammed for outputs, it is capable of sinking 10 mA and sourcing a 1 mA on each pin

All input/output lines are TTL compatible as both inputs and outputs. Ports B and C are CMOS compatible as inputs. Port A may be made CMOS compatible as outputs with a mask option. The address map in Figure 6 gives the address of data registers and DDRs. The register configuration is provided in Figure 20 and Figure 21 provides some examples of port connections.

Caution: The corresponding DDRs for ports A, B, and C are write-only registers (registers at \$004, \$005, and \$006). A read operation on these registers is undefined. Since BSET and BCLR are read/modify/write functions, they cannot be used to set or clear a DDR bit (all "unaffected" bits would be set). It is recommended that all DDR bits in a port be written using a single store instruction.

The latched output data bit (see Figure 19) may always be written. Therefore, any write to a port writes all of its data bits even though the port DDR is set to input. This may be used to initialize the data registers and avoid undefined outputs, however, care must be exercised when using read/modify/write instructions since the data read corresponds to the pin level of the DDR is an input (0) and corresponds to the latched output data when the DDR is an output (1)

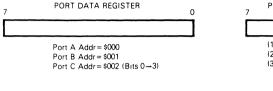
FIGURE 19 - TYPICAL PORT I/O CIRCUITRY

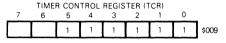


^{*}DDR is a write-only register and reads as all 1's

^{**}Ports A (with CMOS drive disabled), B, and C are three-state ports. Port A has optional internal pullup devices to provide CMOS drive capability. See Electrical Characteristics tables for complete information.

FIGURE 20 - MCU REGISTER CONFIGURATION





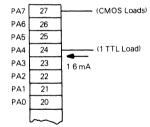
TCR7 – Timer Interrupt Status Request Bit Set when TDR goes to zero, must be cleared by software Cleared to 0 by Reset TCR6 Bit 6 – Timer Interrupt Mask Bit 1 = timer inter-

rupt masked (disabled) Set to 1 by Reset TCR Bits 5, 4, 3, 2, 1, 0 read 1's – unused bits

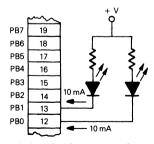
7 PORT DATA DIRECTION REGISTER (DDR) 0 (1) Write Only, reads as all 1's (2) 1 = Output, 0 = Input Cleared to 0 by Reset (3) Port A Addr = \$004 Port B Addr = \$005 Port C Addr = \$006 (Bits 0 - 3) TIMER DATA REGISTER (TDR) 7 MSB LSB \$008

FIGURE 21 — TYPICAL PORT CONNECTIONS

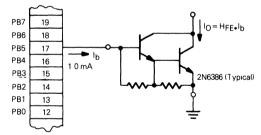
a. Output Modes



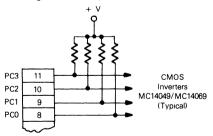
Port A, Bit 7 Programmed as Output, Driving CMOS Loads and Bit 4 Driving one TTL Load Directly (using CMOS output option)



Port B, Bit 0 and Bit 1 Programmed as Output, Driving LEDs Directly

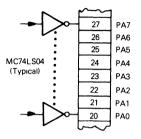


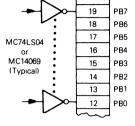
Port B, Bit 5 Programmed as Output, Driving Darlington-Base Directly



Port C, Bits 0, 3 Programmed as Output, Driving CMOS Loads, Using External Pullup Resistors

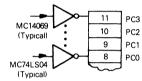
FIGURE 21 — TYPICAL PORT CONNECTIONS (CONTINUED)
b. Input Modes





TTL Driving Port A Directly

CMOS or TTL Driving Port B Directly



CMOS and TTL Driving Port C Directly

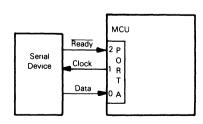
BIT MANIPULATION

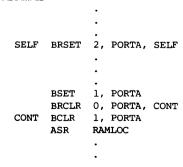
The MC6805P4 MCU has the abilitity to set or clear any single random access memory or input/output bit (except the Data Direction Register, see Caution under INPUT/OUT-PUT paragraph), with a single instruction (BSET, BCLR) Any bit in page zero including ROM, except the DDRs, can be tested, using the BRSET and BRCLR instructions, and the program branches as a result of its state. The Carry bit equals the value of the bit referenced by BRSET or BRCLR A Rotate instruction may then be used to accumulate serial input data in a RAM location or register. The capability to work with any bit in RAM, ROM, or I/O allows the user to

have individual flags in RAM or to handle I/O bits as control lines

The coding example in Figure 22 illustrates the usefulness of the bit manipulation and test instructions. Assume that the MCU is to communicate with an external serial device. The external device has a data ready signal, a data output line, and clock line to clock data one bit at a time, LBS first, out of the device. The MCU waits until the data is ready, clocks the external device, picks up the data in the Carry Flag (C-bit), clears the clock line, and finally accumulates the data bit in a RAM location.

FIGURE 22 - BIT MANIPULATION EXAMPLE





ADDRESSING MODES

The MC6805P4 MCU has 10 addressing modes which are explained briefly in the following paragraphs. For additional details and graphical illustrations, refer to the M6805 Family User's Manual

The term "effective address" (EA) is used in describing the address modes. EA is defined as the address from which the argument for an instruction is fectched or stored.

IMMEDIATE — In the immediate addressing mode, the operand is contained in the byte immediately following the opcode. The immediate addressing mode is used to access constants which do not change during program execution (e.g., a constant used to initialize a loop counter).

DIRECT — In the direct addressing mode, the effective address of the argument is contained in a single byte following the opcode byte. Direct addressing allows the user to directly address the lowest 256 bytes in memory with a single 2-byte instruction. This includes the on-chip RAM and I/O registers and 128 bytes of ROM. Direct addressing is an effective use of both memory and time.

EXTENDED — In the extended addressing mode, the effective address of the argument is contained in the two bytes following the opcode Instructions using extended addressing are capable of referencing arguments anywhere in memory with a single 3-byte instruction. When using the Motorola assembler, the programmer need not specify whether an instruction uses direct or extended addressing. The assembler automatically selects the shortest form of the instruction.

RELATIVE — The relative addressing mode is only used in branch instructions. In relative addressing, the contents of the 8-bit signed byte following the opcode (the offset) is added to the PC if and only if the branch condition is true. Otherwise, control proceeds to the next instruction. The span of relative addressing is from —126 to +129 from the opcode address. The programmer need not worry about calculating the correct offset when using the Motorola assembler, since it calculates the proper offset and checks to see if it is within the span of the branch.

INDEXED, NO OFFSET — In the indexed, no offset addressing mode, the effective address of the argument is contained in the 8-bit index register. Thus, this addressing mode can access the first 256 memory locations. These instructions are only one byte long. This mode is often used to move a pointer through a table or to hold the address of a frequently referenced RAM or I/O location.

INDEXED, 8-BIT OFFSET — In the indexed, 8-bit offset addressing mode, the effective address is the sum of the contents of the unsigned 8-bit index register and the unsigned byte following the opcode. This addressing mode is useful in selecting the kth element in an n element table. With this 2-byte instruction, k would typically be in X with the address of the beginning of the table in the instruction. As such tables may begin anywhere within the first 256 addressable locations and could extend as far as location 511 (\$1FE)

INDEXED, 16-BIT OFFSET — In the indexed, 16-bit offset addressing mode, the effective address is the sum of the contents of the unsigned 8-bit index register and the two unsigned bytes following the opcode. This addressing mode can be used in a manner similar to indexed, 8-bit offset, except that this 3-byte instruction allows tables to be anywhere in memory.

BIT SET/CLEAR — In the bit set/clear addressing mode, the bit to be set or cleared is part of the cpcode, and the byte following the opcode specifies the address of the byte in which the specified bit is to be set direct or cleared. Thus, any read/write bit in the first 256 locations of memory, including I/O, can be selectively set or cleared with a single 2-byte instruction. See Caution under the INPUT/OUTPUT paragraph.

BIT TEST AND BRANCH — The bit test and branch addressing mode is a combination of direct addressing and relative addressing. The bit and condition (set or clear) which is to be tested is included in the opcode, and the address of the byte to be tested is in the single byte immediately following the opcode byte. The signed relative 8-bit offset is in the third byte and is added to the value of the PC if the branch condition is true. This single 3-byte instruction allows the program to branch based on the condition of any readable bit in the first 256 locations of memory. The span of branching is from +130 to -125 from the opcode address. The state of the tested bit is also transfered to the Carry bit of the Condition. Code. Register. See Caution under the INPUT/OUTPUT paragraph.

INHERENT — In the inherent addressing mode, all the information necessary to execute the instruction is contained in the opcode. Operations specifying only the index register or accumulator, as well as control instruction with no other arguments, are included in this mode. These instructions are one byte long.

INSTRUCTION SET

The MC6805P4 MCU has a set of 59 basic instructions, which when combined with the 10 addressing modes produce 207 usable opcodes. They can be divided into five different types, register/memory, read/modify/write, branch, bit manipulation, and control. The following paragraphs briefly explain each type. All the instructions within a given type are presented in individual tables

REGISTER/MEMORY INSTRUCTIONS — Most of these instructions use two operands. One operand is either the accumulator or the index register. The other operand is obtained from memory using one of the addressing modes. The jump unconditional (JMP) and jump to subroutine (JSR) instructions have no register operands. Refer to Table 2.

READ/MODIFY/WRITE INSTRUCTIONS — These instructions read a memory location or a register, modify or test its contents, and write the modified value back to memory or to the register (see Caution under INPUT/OUT-PUT paragraph) The test for negative or zero (TST) instruction is included in read/modify/write instructions though it does not perform the write. Refer to Table 3

MC6805P4

BRANCH INSTRUCTIONS — The branch instructions cause a branch from the program when a certain condition is met. Refer to Table 4

BIT MANIPULATION INSTRUCTIONS — These instructions are used on any bit in the first 256 bytes of the memory (see Caution under INPUT/OUTPUT paragraph). One group either sets or clears. The other group performs the bit test branch operations. Refer to Table 5.

CONTROL INSTRUCTIONS — The control instructions control the MCU operations during program execution Refer to Table 6

ALPHABETICAL LISTING — The complete instruction set is given in alphabetical order in Table 7

 $\mbox{OPCODE MAP SUMMARY}-\mbox{Table 8}$ is an opcode map for the instructions used on the MCU

TABLE 2 — REGISTER/MEMORY INSTRUCTIONS

| | | | | | | | | | A | ddressin | a Mode | es | | | | | | | |
|---|----------|------------|------------|-------------|------------|------------|-------------|------------|------------|-------------|------------|------------|-------------|------------|------------|-------------|------------|------------------|-------------|
| | | | lmmed | ıate | | Direc | ;t | | Extend | | , T | Index | | (8 | Index | | (10 | Index 6 Bit C | |
| Function | Mnemonic | Op Code | # Bytes | # Cycles | Op Code | # Bytes | # Cycles | Op Code | # Bytes | # Cycles | Op Code | # Bytes | # Cycles | Op Code | # Bytes | # Cycles | OP Code | # Bytes | # Cycles |
| Load A from Memory | LDA | A6 | 2 | 2 | В6 | 2 | 4 | C6 | 3 | 5 | F6 | 1 | 4 | E6 | 2 | 5 | D6 | 3 | 6 |
| Load X from Memory | LDX | AE | 2 | 2 | BE | 2 | 4 | CE | 3 | 5 | FE | 1 | 4 | EE | 2 | 5 | DE | 3 | 6 |
| Store A in Memory | STA | - | | | В7 | 2 | 5 | C7 | 3 | 6 | F7 | 1 | 5 | E 7 | 2 | 6 | D7 | 3 | 7 |
| Store X in Memory | STX | - | - | | BF | 2 | 5 | CF | 3 | 6 | FF | 1 | 5 | EF | 2 | 6 | DF | 3 | 7 |
| Add Memory to A | ADD | AB | 2 | 2 | вв | 2 | 4 | CB | 3 | 5 | FB | 1 | 4 | EB | 2 | 5 | DB | 3 | 6 |
| Add Memory and Carry to A | ADC | Α9 | 2 | 2 | В9 | 2 | 4 | С9 | 3 | 5 | F9 | 1 | 4 | E9 | 2 | 5 | D9 | 3 | 6 |
| Subtract Memory | SUB | A0 | 2 | 2 | В0 | 2 | 4 | CO | 3 | 5 | FO | 1 | 4 | EO | 2 | 5 | DO | 3 | 6 |
| Subtract Memory from A with Borrow | SBC | A2 | 2 | 2 | В2 | 2 | 4 | C2 | 3 | 5 | F2 | 1 | 4 | E2 | 2 | 5 | D2 | 3 | 6 |
| AND Memory to A | AND | A4 | 2 | 2 | В4 | 2 | 4 | C4 | 3 | 5 | F4 | 1 | 4 | E4 | 2 | 5 | D4 | 3 | 6 |
| OR Memory with A | ORA | AA | 2 | 2 | BA | 2 | 4 | CA | 3 | 5 | FA | 1 | 4 | EA | 2 | 5 | DA | 3 | 6 |
| Exclusive OR Memory with A | EOR | A8 | 2 | 2 | В8 | 2 | 4 | С8 | 3 | 5 | F8 | 1 | 4 | E8 | 2 | 5 | D8 | 3 | 6 |
| Arithmetic Compare A with Memory | СМР | Α1 | 2 | 2 | В1 | 2 | 4 | C1 | 3 | 5 | F1 | 1 | 4 | E1 | 2 | 5 | D1 | 3 | 6 |
| Arithmetic Compare X with Memory | CPX | А3 | 2 | 2 | в3 | 2 | 4 | С3 | 3 | 5 | F3 | 1 | 4 | E3 | 2 | 5 | D3 | 3 | 6 |
| Bit Test Memory with A (Logical Compare) | ВІТ | A 5 | 2 | 2 | B5 | 2 | 4 | С5 | 3 | 5 | F5 | 1 | 4 | E5 | 2 | 5 | D5 | 3 | 6 |
| Jump Unconditional | JMP | | - | _ | BC | 2 | 3 | CC | 3 | 4 | FC | 1 | 3 | EC | 2 | 4 | DC | 3 | 5 |
| Jump to Subroutine | JSR | - | - | - | BD | 2 | 7 | CD | 3 | 8 | FD | 1 | 7 | ED | 2 | 8 | DD | 3 | 9 |

TABLE 3 - READ/MODIEY/WRITE INSTRUCTIONS

| | | | | IADL | - 3 – | REAU. | IVIODIF | 1/ // | 111611 | SIRUC | HONS | | | | | |
|------------------------------|----------|------------|------------|-------------|------------|------------|-------------|------------|------------|-------------|------------|-----------------|-------------|------------|-----------------|-------------|
| | | | | | | | | Addr | essing | Modes | | | | | | |
| | | | nheren | t (A) | 1 | nheren | t (X) | | Direc | ct | (| Index No Off | | (8 | Index Bit Of | |
| Function | Mnemonic | Op Code | # Bytes | # Cycles | Op Code | # Bytes | # Cycles | Op Code | # Bytes | # Cycles | Op Code | # Bytes | # Cycles | Op Code | # Bytes | # Cycles |
| Increment | INC | 4C | 1 | 4 | 5C | 1 | 4 | 3C | 2 | 6 | 7C | 1 | 6 | 6C | 2 | 7 |
| Decrement | DEC | 4A | 1 | 4 | 5A | 1 | 4 | 3A | 2 | 6 | 7A | 1 | 6 | 6A | 2 | 7 |
| Clear | CLR | 4F | 1 | 4 | 5F | 1 | 4 | 3F | 2 | 6 | 7F | 1 | 6 | 6F | 2 | 7 |
| Complement | сом | 43 | 1 | 4 | 53 | 1 | 4 | 33 | 2 | 6 | 73 | 1 | 6 | 63 | 2 | 7 |
| Negate (2 s Complement) | NEG | 40 | 1 | 4 | 50 | 1 | 4 | 30 | 2 | 6 | 70 | 1 | 6 | 60 | 2 | 7 |
| Rotate Left Thru Carry | ROL | 49 | 1 | 4 | 59 | 1 | 4 | 39 . | 2 | 6 | 79 | 1 | 6 | 69 | 2 | 7 |
| Rotate Right Thru Carry | ROR | 46 | 1 | 4 | 56 | 1 | 4 | 36 | 2 | 6 | 76 | 1 | 6 | 66 | 2 | 7 |
| Logical Shift Left | LSL | 48 | 1 | 4 | 58 | 1 | 4 | 38 | 2 | 6 | 78 | 1 | 6 | 68 | 2 | 7 |
| Logical Shift Right | LSR | 44 | 1 | 4 | 54 | 1 | 4 | 34 | 2 | 6 | 74 | 1 | 6 | 64 | 2 | 7 |
| Arithmetic Shift Right | ASR | 47 | 1 | 4 | 57 | 1 | 4 | 37 | 2 | 6 | 77 | 1 | 6 | 67 | 2 | 7 |
| Test for Negative or Zero | TST | 4D | 1 | 4 | 5D | 1 | 4 | 3D | 2 | 6 | 7D | 1 | 6 | 6D | 2 | 7 |

TABLE 4 - BRANCH INSTRUCTIONS

| | | Relative | Address | ng Mode |
|--|----------|----------|---------|---------|
| | | Op | # | # |
| Function | Mnemonic | Code | Bytes | Cycles |
| Branch Always | BRA | 20 | 2 | 4 |
| Branch Never | BRN | 21 | 2 | 4 |
| Branch IFFHigher | ВНІ | 22 | 2 | 4 |
| Branch IFF Lower or Same | BLS | 23 | 2 | 4 |
| Branch IFF Carry Clear | BCC | 24 | 2 | 4 |
| (BranchIFFHigher or Same) | (BHS) | 24 | 2 | 4 |
| Branch IFF Carry Set | BCS | 25 | 2 | 4 |
| (BranchIFF Lower) | (BLO) | 25 | 2 | 4 |
| Branch IFF Not Equal | BNE | 26 | 2 | 4 |
| Branch IFF Equal | BEQ | 27 | 2 | 4 |
| Branch Half Carry Clear | внсс | 28 | 2 | 4 |
| Branch IFF Half Carry Set | BHCS | 29 | 2 | 4 |
| BranchIFF Plus | BPL | 2A | 2 | 4 |
| BranchIFF Minus | ВМІ | 2B | 2 | 4 |
| Branch IFF Interupt Mask Bit is Clear | вмс | 2C | 2 | 4 |
| Branch IFF Interrupt Mask Bit is Set | BMS | 2D | 2 | 4 |
| Branch IFF Interrupt Line is Low | BIL | 2E | 2 | 4 |
| Branch IFF Interrupt Line is High | ВІН | 2F | 2 | 4 |
| Branch to Subroutine | BSR | AD | 2 | 8 |

TABLE 5 - BIT MANIPULATION INSTRUCTIONS

| | | Addressing Modes | | | | | | | | |
|---------------------------|-------------------|-----------------------------------|-------|--------|------------|-------|--------|--|--|--|
| | | Bit Set/Clear Bit Test and Branch | | | | | | | | |
| | | Op | # | # | Ор | # | = | | | |
| Function | Mnemonic | Code | Bytes | Cycles | Code | Bytes | Cycles | | | |
| Branch IFF Bit n is set | BRSET n (n = 0 7) | | _ | _ | 2 • n | 3 | 10 | | | |
| Branch IFF Bit n is clear | BRCLR n (n = 0 7) | _ | _ | | 01 + 2 • n | 3 | 10 | | | |
| Set Bit n | BSET n (n = 0 7) | 10 + 2 • n | 2 | 7 | _ | _ | - | | | |
| Clear bit n | BCLR n (n = 0 7) | 11 + 2 • n | 2 | 7 | _ | _ | _ | | | |

TABLE 6 - CONTROL INSTRUCTIONS

| | | | Inherent | |
|--------------------------|----------|------|----------|--------|
| | | Op | # | # |
| Function | Mnemonic | Code | Bytes | Cycles |
| Transfer A to X | TAX | 97 | 1 | 2 |
| Transfer X to A | TXA | 9F | 1 | 2 |
| Set Carry Bit | SEC | 99 | 1 | 2 |
| Clear Carry Bit | CLC | 98 | 1 | 2 |
| Set Interrupt Mask Bit | SEI | 9B | 1 | 2 |
| Clear Interrupt Mask Bit | CLI | 9A | 1 | 2 |
| Software Interrupt | SWI | 83 | 1 | 11 |
| Return from Subroutine | RTS | 81 | 1 | 6 |
| Return from Interrupt | RTI | 80 | 1 | 9 |
| Reset Stack Pointer | RSP | 9C | 1 | 2 |
| No-Operation | NOP | 9D | 1 | 2 |

TABLE 7 - INSTRUCTION SET

| | Γ | | | Ac | dressing | Modes | | | | | Co | Condition Code | | | |
|----------|--|--------------|--|--|--|------------------------|--|----------------------|--|--|----------|----------------|---------------|----|----|
| Mnemonic | Inherent | Immediate | Direct | | | Indexed (No Offset) | | Indexed (16 Bits) | | Bit Test & Branch | | | N | | C |
| ADC | | × | X | X | | × | X | X | | | ٨ | • | Λ | ٨ | ٨ |
| ADD | | × | X | Х | | X | X | X | | | \wedge | • | ^ | 1 | _ |
| AND | | × | Х | X | | X | X | X | | | • | | ٨ | _ | • |
| ASL | X | | X | | | X | Х | | | | • | • | ^ | _ | ^ |
| ASR | X | | X | | | X | X | | | | • | • | $\overline{}$ | 1 | _ |
| BCC | | | | | X | | | | | † | • | • | | | • |
| BCLR | | | | † | | | | | X | - | • | • | • | | • |
| BCS | | | | | X | | | | | | • | • | • | • | • |
| BEQ | | | | <u> </u> | X | | - | | 1 | | • | • | • | • | • |
| внсс | 1 | | | | X | | <u> </u> | | | | | • | | • | • |
| BHCS | + | <u> </u> | | | X | | | | - | - | | | • | • | • |
| BHI | | | | | X | | † | | | | | | • | • | • |
| BHS | | <u> </u> | | t | X | | | | | | • | • | • | • | • |
| ВІН | + | | | | X | | | | | | | • | • | • | • |
| BIL | + | | | 1 | X | | - | - | | | • | • | • | • | • |
| BIT | | × | × | X | ^ | X | X | × | | | • | • | ^ | ^ | • |
| BLO | | | | | X | | <u> </u> | <u> </u> | - | | | - | • | | • |
| BLS | | - | | | 1 × | | - | | - | | • | • | • | • | • |
| BMC | | | ļ | <u> </u> | X | | | | | | • | • | • | • | |
| BMI | | | | ļ | ^ | | | | | | • | - | - | +- | • |
| BMS | | + | | <u> </u> | | | | | | ļ | - | • | • | • | 1- |
| BNE | | | | | ļ | | | | ļ | | • | • | • | • | • |
| | _ | - | | ļ | ļ | | | | | ļ | • | • | • | • | • |
| BPL | | | | | | | | | | | • | • | • | • | • |
| BRA | ļ | - | | | | | - | | <u> </u> | | • | • | • | • | • |
| BRN | _ | | | | | | | | L | | • | • | • | • | • |
| BRCLR | | | | - | | | | | | X | • | • | • | • | ^ |
| BRSET | ļ | | ļ | - | | ļ | | | L | × | • | • | • | • | |
| BSET | | | | | ļ | | | | X | | • | • | • | • | • |
| BSR | | | | | Х | | | | <u></u> | | • | • | • | • | • |
| CLL | X | | | | ļ | | | | | | • | • | • | • | 0 |
| CLI | X | 1 | | | | | | <u> </u> | <u> </u> | | • | 0 | | • | • |
| CLR | × | | × | | | X | X | | | | • | • | - | 1 | • |
| СМР | | × | X | X | | X | X | X | | | • | • | 1 | Λ | ^ |
| сом | X | | X | | | X | X | | <u> </u> | | • | • | ^ | ^ | 1 |
| CPX | | × | Х | Х | | Х | X | X | | | • | • | ^ | Λ | ^ |
| DEC | X | | X | | | Х | Х | | | | • | • | ^ | ٨ | • |
| EOR ' | 1 | X | X | X | | X | X | Х | | | • | • | Λ | ٨ | • |
| INC | × | | Х | | | X | Х | | | | • | • | ٨ | ٨ | • |
| JMP | | | X | X | | X | X | X | | | • | • | • | • | • |
| JSR | | | X | X | | X | × | × | | | • | • | • | • | • |
| LDA | | X | X | X | | X | Х | X | | | • | • | ٨ | ٨ | • |
| LDX | | X | X | X | | X | X | × | | | • | • | ٨ | ٨ | • |
| LSL | X | | X | | 1 | X | × | | | | • | • | 1 | ٨ | ^ |
| LSR | × | | × | | | X | X | | | | • | • | 0 | ٨ | ^ |
| NEQ | X | | × | 1 | | X | × | | 1 | T | • | | ^ | ٨ | ^ |
| NOP | X | | | | | | | | | 1 | • | • | • | • | • |
| ORA | | X | × | X | 1 | X | X | X | 1 | | • | • | $\overline{}$ | ^ | • |
| ROL | X | | X | † | | X | × | | † | † | • | • | 1 | ^ | ^ |
| RSP | X | | | | + | | | t | 1 | † | | | _ | | |

Condition Code Symbols

- Ondition Code Symbols
 H Half Carry (From Bit 3)
 I Interrupt Mask
 Not Affected
- I Interrupt Mask
 N Negative (Sign Big)
- Z Zero

- ↑ Test and Set if True, Cleared Otherwise
 Not Affected

TABLE 7 - INSTRUCTION SET (CONTINUED)

| | | | | A | ddressing | Modes | | | | Сс | nd | itio | n C | ode |
|----------|----------|-----------|--------|----------|-----------|------------------------|---|----------------------|-------------------------|----|----|------|-----|-----|
| Mnemonic | Inherent | Immediate | Direct | Extended | Relative | Indexed (No Offset) | | Indexed (16 Bits) | Bit Test & Branch | н | | N | Z | С |
| RTI | X | | | | | | | | |) | 7 | 7 | 7 |) |
| RTS | X | | | | | | | | | • | • | • | • | • |
| SBC | | × | Х | X | i | × | X | X | | • | • | ٨ | Λ | ^ |
| SEC | X | | | | | | | | | • | • | • | • | 1 |
| SEI | X | | | | | | | 1 | | • | 1 | • | • | • |
| STA | | | Х | X | | X | × | × | | • | • | ^ | Λ | • |
| STX | | | Х | X | | × | × | X | | • | • | ٨ | Λ | • |
| SUB | | × | × | X | | × | × | × | | • | • | Λ | Λ | ^ |
| SWI | Х | | | | | | | | | • | 1 | • | • | • |
| TAX | X | | | | | | | | | • | • | • | • | • |
| TST | X | | X | | | X | × | | | • | • | ^ | ^ | • |
| TXA | Х | | | | | | | | | • | • | • | • | • |

Condition Code Symbols

- H Half Carry (From Bit 3)
- I Interrupt Mask
 N Negative (Sign Big)
 Z Zero

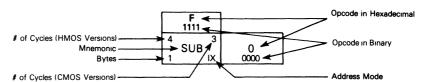
- C Carry/Borrow
- Λ Test and Set if True, Cleared Otherwise
- Not Affected
- 2 Load CC Register From Stack

TABLE 8 - M6805 FAMILY OPCODE MAP

| | Bit Mar | ipulation | Branch | | Re | ad/Modify/ | Write | | Cor | itrol | | | Registe | r/Memory | | | Γ |
|-----------|-----------------------------------|----------------------------------|----------------------------|---------------------|---------------------------|------------------------|---------------------|----------------------|-----------------------------|-----------------------|---------------------|----------------------------|------------------------------|----------------------------|------------------------------|----------------------|----------------|
| | BTB | BSC | REL | DIR | INH(A) | INH(X) | IX1 6 | IX | INH | INH | IMM | DIR | EXT | IX2 | IX1 | IX F | |
| Low Hi | 0000 | 0001 | 0010 | 0011 | 0100 | 5 0101 | 6 0110 | 0111 | 1000 | 9 1001 | 1010 | B 1011 | 1100 | D 1101 | E 1110 | 1111 | HI LOW |
| 0000 | BRSETO 3 BTB | 7 BSETO 2 BSC | 4 BRA 2 REL | 6 5 NEG 2 DIR | | | | 6 NEG 1 IX | 9 9 RTI 1 INH | | SUB 2 IMM | 4 SUB 2 DIR | SUB 3 EXT | 6 5 SUB 3 IX2 | SUB 2 IX1 | SUB IX | 0000 |
| 1 0001 | BRCLRO BR BTB | BCLR0 2 BSC | BRN 2 REL | | | | | | 6 RTS 1 INH | | CMP 2 IMM | CMP DIR | 5 CMP 3 EXT | 6 CMP 3 ix2 | 5 CMP 2 IX1 | CMP IX | 1 0001 |
| 2 0010 | BRSET1 | 7 BSET1 2 BSC 7 5 | 4 BHI 2 REL | 6 5 | 4 3 | 4 3 | 7 6 | 6 5 | 11 10 | | SBC 2 | SBC 3 | 5 SBC 3 EXT | SBC IX2 | 5 SBC 2 IX1 | SBC IX | 2 0010 |
| 3 0011 | 10 5 BRCLR1 3 BTB | BCLR1 BSC | BLS 2 REL | COM DIR | COMA 1 INH | COMX 1 INH | COM 1X1 | COM | SWI 1 INH | | CPX 2 IMM | CPX 2 DIR 3 | CPX 3 EXT | CPX 3 IX2 | CPX 2 IX1 | CPX IX | 3 0011 |
| 0100 | BRSET2 3 BTB | BSET2 2 BSC 7 5 | BCC REL | LSR DIR | LSRA INH | LSRX 1 INH | LSR 2 IX1 | LSR | | | AND 2 IMM 2 | AND DIR | AND 3 EXT | AND 3 IX2 | AND 2 1X1 5 4 | AND 1X | 4 0100 |
| 5 0101 | BRCLR2 3 BTB | BCLR2 2 BSC 7 5 | BCS 2 REL 4 3 | 6 5 | 4 3 | 4 3 | 7 6 | 6 5 | | | BIT 2 IMM 2 2 | BIT 2 DIR 4 3 | BIT 3 EXT 5 4 | | BIT 2 IX1 5 4 | BIT 1X 4 3 | 5 0101 |
| 6 0110 | BRSET3 3 BTB 10 5 | BSET3 2 BSC 7 5 | BNE REL 3 | ROR 2 DIR 6 5 | RORA 1 INH 4 3 | RORX 1 INH 4 3 | ROR 2 IX1 7 6 | ROR 1 IX 6 5 | | 2 2 | LDA 2 IMM | LDA 2 DIR 5 4 | 6 5 | 7 6 | LDA 2 IX1 6 5 | LDA 1 IX 5 4 | 6 0110 |
| 7 0111 | BRCLR3 3 BTB 10 5 | BCLR3 2 BSC 7 5 | BEQ 2 REL 4 3 | ASR 2 DIR 6 5 | ASRA 1 INH 4 3 | ASRX 1 INH 4 3 | ASR 2 ix1 7 6 | ASR 1 IX 6 5 | | TAX 1 INH 2 2 | 2 2 | STA 2 DIR 4 3 | STA 3 EXT 5 4 | | STA 2 IX1 5 4 | STA 1 IX 4 3 | 7 0111 |
| 1000 | BRSET4 3 BTB 10 5 | BSET4 2 BSC 7 5 | BHCC 2 REL 4 3 | | | LSLX 1 INH 4 3 | | LSL 1 IX 6 5 | | CLC 1 INH 2 2 | EOR 2 IMM 2 2 | EOR 2 DIR 4 3 | | EOR 3 1X2 6 5 | EOR 2 IX1 5 4 | | 1000 |
| 1001 | BRCLR4 3 BTB | BCLR4 2 BSC 7 5 | | | | ROLX 1 INH 4 3 | | ROL 1 IX 6 DEC | | SEC 1 INH 2 2 | ADC 2 IMM 2 2 | ADC 2 DIR 4 3 | | | ADC 2 IX1 5 004 | | 9 1001 |
| 1010 | BRSET5 3 BTB 10 5 BRCLR5 | BSET5 2 BSC 7 | BPL 2 REL 4 3 BMI | DEC 2 DIR | DECA 1 INH | DECX 1 INH | DEC 2 IX1 | DEC IX | | CLI 1 INH 2 2 | ORA 2 IMM 2 2 | ORA 2 DIR 4 3 | | | ORA 2 1X1 5 4DD | ORA 1 IX 4 ADD | A 1016 B |
| B 1011 | 3 BTB 10 5 BRSET6 | BCLR5 2 BSC 7 5 BSET6 | 2 REL | 6 INC | 4 INCA 3 | 4 INCX 3 | 7 INC 6 | 6 INC | | SEI 1 INH 2 RSP | ADD 2 IMM | ADD 2 DIR 3 2 JMP | ADD 3 EXT 4 3 | | ADD 2 1X1 4 3 JMP | 1 IX 3 JMP | 1011 C |
| 1100 D | 3 BTB 10 5 BRCLR6 | BSE 16 BSC BSC 5 | 2 REL 4 BMS | 2 DIR 6 4 TST | 1 INCA 1 INH 4 TSTA | 1 INCX 1 INH 4 3 | 2 INC 7 5 | 1 IX 6 TST | | 1 INH 2 2 NOP | 8 BSR 6 | 2 DIR 7 5 JSR | 3 EXT 8 6 | JMP 3 1X2 9 7 JSR | 2 IX1 8 6 JSR | JMP 1 IX 7 S | 1100 D |
| 1101 E | 3 BTB 10 5 BRSET7 | BSET7 | 2 REL 4 3 BIL | 2 DIR | 1 INH | 1 INH | 2 IX1 | 1 1X | STOP 2 | 1 INH | 2 REL 2 LDX | 2 DIR 4 DIR | 3 EXT 5 LDX | 3 1X2 6 5 LDX | 2 IX1 5 LDX | 1 IX 4 LDX | 1101 E |
| 1110 F | 3 BTB 10 5 BRCLR7 | 2 BSC 7 5 BCLR7 2 BSC | 2 REL 4 3 BIH | CLR | 4 CLRA | 4 CLRX | 7 6 CLR 2 IX1 | 6 CLR 5 | 1 INH 2 WAIT 1 INH | 2 2 TXA 1 INH | 2 IMM | 2 DIR 5 4 STX | 3 EXT 6 5 STX 3 EXT | 3 X2 6 STX 3 X2 | 2 IX1 6 5 STX 2 IX1 | 5 STX | 111C F |

Abbreviations for Address Modes

INH Inherent IMM Immediate DIR Direct EXT Extended REL Relative BSC Bit Set/Clear ВТВ Bit Test and Branch ΙX Indexed (No Offset) IX1 Indexed, 1 Byte (8-Bit) Offset IX2 Indexed, 2 Byte (16-Bit) Offset CMOS Versions Only



LEGEND

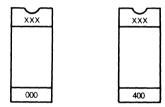
1

ORDERING INFORMATION

The information required when ordering a custom MCU is listed below. The ROM program may be transmitted to Motorola on EPROM(s) or a MDOS disk file.

To initiate a ROM pattern for the MCU it is necessary to first contact your local Motorola representative or Motorola distributor

EPROMs — The MCM2716 or MCM2532 type EPROMs, programmed with the customer program (positive logic sense for address and data), may be submitted for pattern generation. The EPROM must be clearly marked to indicate which EPROM corresponds to which address space. The recommended marking procedure is illustrated below.



XXX = Customer ID

After the EPROM(s) are marked they should be placed in conductive IC carriers and securely packed. Do not use styrofoam

VERIFICATION MEDIA

All original pattern media (EPROMs or Floppy Disk) are filed for contractual purposes and are not returned A computer listing of the ROM code will be generated and returned along with a listing verification form. The listing should be thoroughly checked and the verification form completed,

signed, and returned to Motorola. The signed verification form constitutes the contractual agreement for creation of the customer mask. If desired, Motorola will program on blank EPROM from the data file used to create the custom mask and aid in the verification process.

ROM VERIFICATION UNITS (RVUs)

Ten MCUs containing the customer's ROM pattern will be sent for program verification. These units will have been made using the custom mask but are for the purpose of ROM verification only. For expediency they are usually unmarked, packaged in ceramic, and tested only at room temperature and 5 volts. These RVUs are included in the mask charge and are not production parts. The RVUs are thus not guaranteed by Motorola Quality. Assurance, and should be discarded after verification is completed.

FLEXIBLE DISKS

The disk media submitted must be single-sided, single-density, 8-inch, MDOS compatible floppies. The customer must write the binary file name and company name on the disk with a felt-tip pen. The minimum MDOS system files as well as the absolute binary object file (filename L0 type of file) from the M6805 cross assembler must be on the disk. An object file made from a memory dump using the ROLLOUT command is also acceptable. Consider submitting a source listing as well as the following files filename, LX (EXORciser® loadable format) and filename, SA (ASCII Source Code). These files will of course be kept confidential and are used 1) to speed up the process in-house if any problems arise, and 2) to speed up the user-to-factor interface if the user finds any software errors and needs assistance quickly from Motorola factory representatives.

MDOS is Motorola's Disk Operating system available on development systems such as EXORcisers, EXORsets, etc.

MC6805P4 MCU ORDERING INFORMATION

| Customer Company | |
|---|---|
| Address | MC |
| CityState | SC |
| CountryState | |
| Phone Extension | |
| | |
| Customer Contact Person | |
| Customer Part Number | |
| | |
| OPTION LIST Select the options for your MC | CLI from the following list: A |
| manufacturing maşk will be gene | |
| | |
| Timer Clock Source ☐ Internal ø 2 clock | |
| ☐ TIMER input pin | |
| <u>_</u> pax p | |
| Timer Prescaler | |
| □ 2º (divide by 1) | ☐ 2⁴ (divide by 16) |
| 2¹ (divide by 2) | ☐ 2 ⁵ (divide by 32) |
| ☐ 2² (dıvıde by 4) ☐ 2³ (divıde by 8) | ☐ 2 ⁶ (divide by 64) |
| 2º (divide by 6) | ☐ 2 ⁷ (divide by 128) |
| | D. A. A. C. Arraya Dawara |
| Internal Oscillator Input □ Crystal | Port A Output Drive ☐ CMOS and TTL |
| ☐ Resistor | ☐ TTL Only |
| | |
| Low Voltage Inhibit | Standby RAM |
| ☐ Disable | ☐ 16 Bytes |
| □ Enable | ☐ 64 Bytes |
| | ☐ 112 Bytes |
| Pattern Media (All other media requires prior factory a | approval) |
| ☐ EPROMs (MCM2716 or MCM253 | 32 🗆 Floppy Disk |
| | ☐ Other |
| L | |
| Clock Freq. | |
| Temp. Range 0° to | +70°C (Standard) □ -40° to +85°C* □ -40° to |
| *Requires prior factory approval | |
| Marking Information (12 Characters Maximum) | |
| - | |
| | |
| | |

MOTOROLA

MC6805R2

Advance Information

8-BIT MICROCOMPUTER UNIT WITH A/D

The MC6805R2 Microcomputer Unit (MCU) is a member of the M6805 Family of low-cost single-chip Microcomputers. The 8-bit microcomputer contains a CPU, on-chip CLOCK, ROM, RAM, I/O, 4-channel 8-bit A/D, and TIMER. It is designed for the user who needs an economical microcomputer with the proven capabilities of the M6800-based instruction set A comparison of the key features of several members of the M6805 Family of microcomputers is shown on the last page of this data sheet. The following are some of the hardware and software highlights of the MC6805R2 MCU.

HARDWARE FEATURES:

- 8-Bit Architecture
- 64 Bytes of RAM
- Memory Mapped I/O
- 2048 Bytes of User ROM
- 24 TTL/CMOS Compatible Bidirectional I/O Lines (8 lines are LED Compatible)
- 2 to 5 Digital Input Lines
- A/D Converter
 - 8-Bit Conversion, Monotonic
 - 1 to 4 Multiplexed Analog Inputs
 - ± 1/2 LSB Quantizing Error
 - + 1/2 LSB All Other Errors
 - ±1 LSB Total Error (max)
 - Ratiometric Conversion
- Zero-Crossing Detection
- On-Chip Clock Generator
- Self-Check Mode
- Master Reset
- Complete Development System Support On EXORciser®
- 5 V Single Supply

SOFTWARE FEATURES:

- Similar to M6800 Family
- Byte Efficient Instruction Set
- Easy to Program
- True Bit Manipulation
- Bit Test and Branch Instructions
- Versatile Interrupt Handling
- Versatile Index Register
- Powerful Indexed Addressing for Tables
- Full Set of Conditional Branches
- Memory Usable as Register/Flags
- Single Instruction Memory Examine/Change
- 10 Powerful Addressing Modes
- All Addressing Modes
- User Callable Self-Check Subroutines

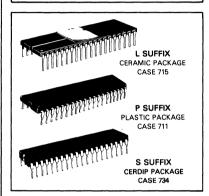
USER SELECTABLE OPTIONS:

- Internal 8-Bit Timer with Selectable Clock Source (External Timer Input or Internal Machine Clock)
- Timer Prescaler Option (7 Bits 2N)
- 8 Bidirectional I/O Lines with TTL or TTL/CMOS Interface Option
- Crystal or Low-Cost Resistor Oscillator Option
- Low Voltage Inhibit Option
- 4 Vectored Interrupts, Timer, Software, and 2 External

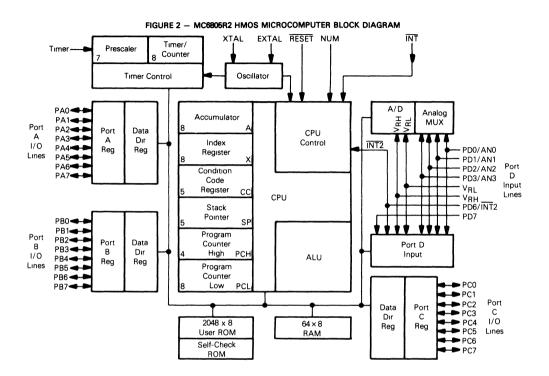
HMOS

(HIGH DENSITY N-CHANNEL, SILICON-GATE DEPLETION LOAD)

8-BIT MICROCOMPUTER WITH A/D



| FIGUR | E 1 — PIN ASSIG | NMI | ENTS |
|--------------------------|-----------------|-----|--------------|
| ٧ _{SS} I | | 40 | PA7 |
| RESET | 2 | 39 | PA6 |
| ī nt [| 3 | 38 | IPA5 |
| Vcc [| 4 | 37 | PA4 |
| EXTAL [| 5 | 36 | PA3 |
| XTAL[| 6 | 35 | PA2 |
| NUM [| 7 | 34 | PA1 |
| TIMER | 8 | 33 | PA0 |
| PC0 | 9 | 32 | 1 PB7 |
| PC1 [| 10 | 31 |] РВ6 |
| PC2 | 11 | 30 | 1 PB5 |
| PC3 [| 12 | 29 |] PB4 |
| PC4 [| 13 | 28 |] PB3 |
| PC5 | 14 | 27 | PB2 |
| PC6 [| 15 | 26 |] PB1 |
| PC7 £ | 16 | 25 | IPB0 |
| PD7 | 17 | 24 | PD0/AN0 |
| PD6/INT2 | 18 | 23 | PD1/AN1 |
| V _{RH} ⊑ | 19 | 22 | PD2/AN2 |
| ∨ _{RL} I | 20 | 21 | PD3/AN3 |
| • | | | |



MAXIMUM RATINGS

| Rating | Symbol | Value | Unit |
|--------------------------------------|------------------|-------------|------|
| Supply Voltage | V _{CC} | -03 to +70 | V |
| Input Voltage | V _{in} | -03 to +70 | V |
| Operating Temperature Range | TA | 0 to 70 | °C |
| Storage Temperature Range | T _{stg} | -55 to +150 | °C |
| Junction Temperature Plastic Package | | 150 | |
| Ceramic Package Cerdip | TJ | 175 175 | °C |

THERMAL CHARACTERISTICS

| Characteristic | Symbol | Value | Unit |
|--|------------------|-----------------|------|
| Thermal Resistance Plastic Ceramic Cerdip | $\theta_{ m JA}$ | 100 50 60 | °C/W |

Stresses above those listed under "Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. Reliability of operation is enhanced if unused inputs are tied to an appropriate logic voltage level (e.g., either VSS or VCC).

(1)

POWER CONSIDERATIONS

The average chip-junction temperature, T.j., in °C can be obtained from:

$$T_J = T_A + (P_D \bullet \theta_{JA})$$
Where
 $T_A = Ambient Temperature, °C$

θ J A ≡ Package Thermal Resistance, Junction-to-Ambient, °C/W

PD = PINT + PPORT

PINT = ICC × VCC, Watts - Chip Internal Power

PPORT = Port Power Dissipation, Watts - User Determined

For most applications PPORT ◆PINT and can be neglected PPORT may become significant if the device is configured to drive Darlington bases or sink LED loads

An approximate relationship between PD and TJ (if PPORT is neglected) is:

$$P_D = K - (T_J + 273 \,^{\circ}C)$$
 (2)

Solving equations 1 and 2 for K gives.

$$K = P_D \bullet (T_A + 273^{\circ}C) + \theta_{JA} \bullet P_D^2$$

Where K is a constant pertaining to the particular part. K can be determined from equation 3 by measuring P_D (at equilibrium) for a known T_A . Using this value of K the values of P_D and T_J can be obtained by solving equations (1) and (2) iteratively for any value of T_A .

ELECTRICAL CHARACTERISTICS (V_{CC} = +5 25 Vdc ±0 5 Vdc, V_{SS} = GND, T_A = 0° to 70°C Unless Otherwise Noted)

| Characteristic | Symbol | Min | Тур | Max | Unit |
|---|--------------------|--|--------------------|---------------------------------|---------------------|
| Input High Voltage RESET (4 75≤V _{CC} ≤5 75) (V _{CC} <4 75) INT (4 75≤V _{CC} ≤5 75) (V _{CC} <4 75) All Other | V _{IH} | 40 V _{CC} -05 40 V _{CC} -05 20 | - * * | Vcc Vcc Vcc Vcc Vcc | V |
| Input High Voltage Timer Timer Mode Self-Check Mode | VIH | 2 0 — | _ 9 0 | V _{CC} 15 0 | V |
| Input Low Voltage RESET INT All Other (Except A/D Inputs) | VIL | -03 -03 -03 | - * - | 08 15 08 | ٧ |
| RESET Hysteresis Voltages (See Figures 11, 12, and 13) "Out of Reset" "Into Reset" | V _{IRES+} | 2 1 0 8 | - | 4 0 2 0 | V |
| INT Zero Crossing Input Voltage, Through a Capacitor | VINT | 2 | _ | 4 | V _{ac p-p} |
| Power Dissipation — No Port Loading V _{CC} =5 75 V, T _A =0°C | PD | - | 600 | _ | mW |
| Input Capacitance EXTAL All Other Except Analog Inputs | C _{in} | _ | 25 10 | _ | pF |
| Low Voltage Recover | VLVR | | _ | 4 75 | ٧ |
| Low Voltage Inhibit | VLVR | - | 35 | _ | V |
| Input Current $ \begin{array}{l} \text{TIMER (V_{In} = 0.4 \text{ V})} \\ \hline \text{INT (V_{In} = 2 4 \text{ V to V}_{CC})} \\ \hline \text{EXTAL (V_{In} = 2 4 \text{ V to V}_{CC} \text{ Crystal Option)} \\ \hline \text{(V_{In} = 0 4 \text{ V Crystal Option)}} \\ \hline \text{RESET (V_{In} = 0 8 \text{ V})} \\ \hline \text{(External Capacitor Charging Current)} \\ \end{array} $ | l _{in} | - - - - -4 0 | 20 | 20 50 10 1600 50 | μΑ |

NOTE Port D Analog Inputs, when selected, $C_{IN} = 25$ pF for the first 5 out or 30 cycles

^{*}Due to internal biasing this input (when unused) floats to approximately 2 0 V

A/D CONVERTER CHARACTERISTICS (V_{CC} = +5 25 Vdc ±0 5 Vdc, V_{SS} = GND, T_A = 0° to 70°C Unless Otherwise Noted)

| Characteristic | Min | Тур | Max | Unit | Comments |
|--------------------------------|-----------------|------------|--------------|------------------|--|
| Resolution | 8 | 8 | 8 | Bits | |
| Non-Linearity | _ | - | ± 1/2 | LSB | For $V_{RH} = 4.0$ to 5.0 V and $V_{RL} = 0$ V |
| Quantizing Error | _ | _ | ± 1/2 | LSB | For $V_{RH} = 4.0$ to 5.0 V and $V_{RL} = 0$ V |
| Conversion Range | VRL | - | VRH | V | |
| V _{RH} | _ | _ | 50 | V | A/D Accuracy may decrease proportionately as |
| V _{RL} | VSS | _ | 0.2 | V | VRH is reduced below 4.0 V. The sum of VRH and |
| | 33 | | | | V _{RL} must not exceed 5 0 V |
| Conversion Time | 30 | 30 | 30 | t _{cyc} | Includes sampling time |
| Monotonicity | Int | nerent (wi | thin total e | rror) | |
| Zero Input Reading | 00 | 00 | 01 | hexadecimal | V _{in} = 0 |
| Ratiometric Reading | FF | FF | FF | hexadecimal | V _{in} = V _{RH} |
| Sample Time | 5 | 5 | 5 | tcyc | |
| Sample/Hold Capacitance, Input | _ | - | 25 | pF | |
| Analog Input Voltage | V _{RL} | _ | VRH | V | Negative transients on V _{RL} are not allowed at any time during conversion |

SWITCHING CHARACTERISTICS (V_{CC}= +5 25 Vdc ± 0.5 Vdc, V_{SS}'= GND, T_A=0° to 70°C Unless Otherwise Noted)

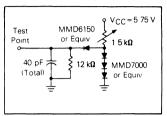
| Characteristic | Symbol | Min | Тур | Max | Unit |
|--|----------|------------------------|-----|-----|------|
| Oscillator Frequency | fosc | 04 | - | 4 2 | MHz |
| Cycle Time (4/f _{OSC}) | tcyc | 0 95 | _ | 10 | μS |
| INT, INT2, and TIMER Pulse Width | tWL, tWH | t _{CYC} + 250 | - | - | ns |
| RESET Pulse Width | tRWL | t _{CyC} + 250 | _ | _ | ns |
| RESET Delay Time (External Cap = 1 μF) | tRHL | - | 100 | _ | ms |
| INT Zero-Crossing Detection Input Frequency (for ±5° Accuracy) | fINT | 0 03 | _ | 1 | kHz |
| External Clock Input Duty Cycle (EXTAL) | _ | 40 | 50 | 60 | % |

PORT ELECTRICAL CHARACTERISTICS (V_{CC} = +5 25 Vdc ±0 5 Vdc, V_{SS} = GND, T_A = 0° to 70°C Unless Otherwise Noted)

| Characteristic | Symbol | Min | Тур | Max | Unit |
|--|------------------|----------|-----|-------|------|
| Port A with CMO | S Drive Enabled | | | | |
| Output Low Voltage I _{Load} =1 6 mA | VOL | | | 0 4 | ٧ |
| Output High Voltage I _{Load} = -100 μA | Voн | 2 4 | - | _ | ٧ |
| Output High Voltage I _{Load} = -10 μA | Voн | 35 | _ | _ | V |
| Input High Voltage I _{Load} = -300 µA (max) | VIH | 20 | - | Vcc | V |
| Input Low Voltage I _{Load} = -500 μA (max) | VIL | -0.3 | _ | 0.8 | ٧ |
| Hi-Z-State Input Current (V _{IN} =20 V to V _{CC}) | ΊΗ | _ | - | - 300 | μА |
| H-Z State Input Current (V _{IN} =0 4 V) | IIL | _ | - | - 500 | μΑ |
| Port B | | | | | |
| Output Low Voltage I _{Load} = 3 2 mA | VOL | _ | _ | 0 4 | V |
| Output Low Voltage I _{Load} = 10 mA (sink) | VOL | _ | _ | 10 | V |
| Output High Voltage I _{Load} = -200 μA | Voн | 2 4 | - | _ | V |
| Darlington Current Drive (Source) V _O =15 V | ЮН | -10 | - | -10 | mA |
| Input High Voltage | VIH | 20 | - | Vcc | V |
| Input Low Voltage | VIL | -03 | - | 08 | ٧ |
| Hı-Z-State Input Current | ^I TSI | _ | 2 | 20 | μА |
| Port C and Port A with | CMOS Device | Disabled | | | |
| Ouput Low Voltage I _{Load} = 1 6 mA | VOL | _ | - | 0 4 | ٧ |
| Output High Voltage I _{Load} = -100 μA | Voн | 2 4 | - | | ٧ |
| Input High Voltage | ViH | 20 | _ | Vcc | ٧ |
| Input Low Voltage | VIL | -0.3 | _ | 0.8 | ٧ |
| Hı-Z-State Input Current | ITSI | _ | 2 | 20 | μΑ |
| Port D (Digital | nputs Only) | | | | |
| Input High Voltage | V _{IH} | 2.0 | _ | Vcc | V |
| Input Low Voltage | VIL | -03 | _ | 0.8 | V |
| Input Current* | l _{in} | - | - | 20 | μА |

^{*}V_{RL}/P_D4 – V_{RH}/P_D5 The A/D conversion resistor (11.6 k nominal) is connected internally between these two lines, impacting their use as digital inputs in some applications.

FIGURE 3 — TTL EQUIVALENT TEST LOAD FIGURE 4 — CMOS EQUIVALENT TEST LOAD (PORT B) (PORT A)



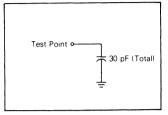
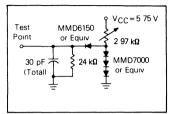


FIGURE 5 — TTL EQUIVALENT TEST LOAD (PORTS A AND C)



SIGNAL DESCRIPTION

The input and output signals for the MCU, shown in Figure 1, are described in the following paragraphs

VCC AND VSS — Power is supplied to the MCU using these two pins VCC is power and VSS is the ground connection

 $\overline{\text{INT}}$ — This pin provides the capability for asynchronously applying an external interrupt to the MCU Refer to INTER-RUPTS for additional information

XTAL AND EXTAL — These pins provide control input for the on-chip clock oscillator circuit. A crystal, a resistor, or an external signal depending on user selectable manufacturing mask option, can be connected to these pins to provide a system clock with various degrees of stability/cost tradeoffs Lead length and stray capacitance on these two pins should be minimized Refer to INTERNAL CLOCK GENERATOR OPTIONS for recommendations about these inputs

TIMER — The pin allows an external input to be used to decrement the internal timer circuitry. Refer to TIMER for additional information about the timer circuitry.

RESET — This pin allows resetting of the MCU at times other than the automatic resetting capability already in the MCU. The MCU can be reset by pulling RESET low. Refer to RESETS for additional information.

NUM (Non-User Mode) — This pin is not for user application and must be connected to V_{SS}

INPUT/OUTPUT LINES (PA0-PA7, PB0-PB7, PC0-PC7, PD0-PD7) — These 30 lines are arranged into three 8-bit ports (A, B, and C) plus port D with 6 inputs Ports A, B, and C are programmable as either inputs or outputs, under software control of the data direction registers Port D has from one to four analog inputs, an INT2 input, and from one to

five digital inputs. All port D lines can also be directly read and used as binary inputs. The voltage reference pins (VRH and VRL) for the A/D converter are also read as a part of port D. Refer to INPUT/OUTPUT, A/D CONVERTER, and INTERRUPTS for additional information.

MEMORY — The MCU is capable of addressing 4096 bytes of memory and I/O registers with its program counter. The MC6805R2 MCU has implemented 2316 of these bytes. This consists of 2048 user ROM bytes, 192 self-check ROM bytes, 64 user RAM bytes, 7 port I/O bytes, 2 timer registers, 2 A/D registers and a miscellaneous register, see Figure 6 for the Address Map. The user ROM has been split into three areas. The first area is memory locations \$080 to \$0FF, and allows the user to access these ROM locations utilizing the direct and table look-up indexed addressing modes. The main user ROM area is from \$7C0 to \$F37. The last 8 user ROM locations at the top of memory are for the interrupt vectors.

The MCU reserves the first 16 memory locations for I/O features, of which 12 have been implemented. These locations are used for the ports, the port DDRs, the timer, the $\overline{\text{INT2}}$ miscellaneous register, and the A/D. Of the 64 RAM bytes, 31 bytes are shared with the stack area. The stack must be used with care when data shares the stack area.

The shared stack area is used during the processing of an interrupt or subroutine calls to save the contents of the CPU state. The register contents are pushed onto the stack in order shown in Figure 7. Since the Stack pointer decrements during pushes, the low order byte (PCL) of the Program Counter is stacked first, then the high order four bits (PCH) are stacked. This ensures that the program counter is loaded correctly during pulls from the stack since the stack pointer increments when it pulls data from the stack. A subroutine call results in only the Program Counter (PCL, PCH) contents bing pushed onto the stack, the remaining CPU registers are not pushed

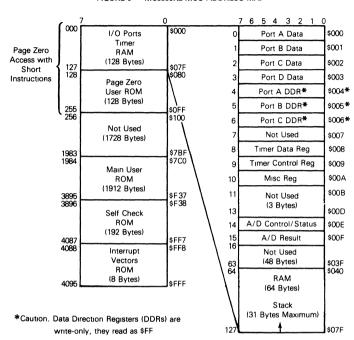
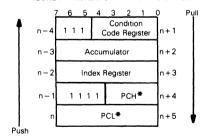


FIGURE 6 - MC6805R2 MCU ADDRESS MAP

FIGURE 7 - INTERRUPT STACKING ORDER



^{*}For subroutine calls, only PCH and PCL are stacked

CENTRAL PROCESSING UNIT

The CPU of the M6805 Family is implemented independently from the I/O or memory configuration. Consequently, it can be treated as an independent central processor communicating with I/O and memory via internal address, data, and control buses.

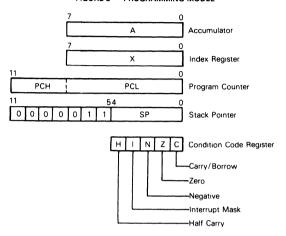
REGISTERS

The M6805 Family CPU has five registers available to the programmer. They are shown in Figure 8 and are explained in the following paragraphs.

ACCUMULATOR (A) — The Accumulator is a general purpose 8-bit register used to hold operands and results of arithmetic calculations or data manipulations

INDEX REGISTER (X) — The Index Register is an 8-bit register used for the indexed addressing mode. It contains an 8-bit value that may be added to an instruction value to create an effective address. The index register can also be used for data manipulations using the read/modify/write instructions. The Index Register may also be used as a temporary storage area.

FIGURE 8 - PROGRAMMING MODEL



PROGRAM COUNTER (PC) — The Program Counter is a 12-bit register that contains the address of the next instruction to be executed

STACK POINTER (SP) — The Stack Pointer is a 12-bit register that contains the address of the next free location on the stack During an MCU reset, or the Reset Stack Pointer (RSP) instruction, the Stack Pointer is set to location \$07F. The Stack Pointer is then decremented as data is pushed onto the stack and incremented as data is then pulled from the stack. The seven most-significant bits of the Stack Pointer are permanently set to 0000011. Subroutines and interrupts may be nested down to location \$061 (31 bytes maximum) which allows the programmer to use up to 15 levels of subroutine calls (less if interrupts are allowed)

CONDITION CODE REGISTERS (CC) — The Condition Code Register is a 5-bit register in which four bits are used to indicate the results of the instruction just executed. These bits can be individually tested by a program and specific action taken as a result of their state. Each bit is explained in the following paragraphs.

Half Carry (H) - Set during ADD and ADC operations to indicate that a carry occurred between bits 3 and 4

Interrupt (I) — When this bit is set, the timer and external interrupts ($\overline{\text{INT}}$ and $\overline{\text{INT}}$ 2) are masked (disabled). If an interrupt occurs while this bit is set, the interrupt is latched and is processed as soon as the interrupt bit is cleared.

Negative (N) — When set, this bit indicates that the result of the last arithmetic, logical, or data manipulation was negative (bit 7 in the result is a logical one)

Zero (Z) — When set, this bit indicates that the result of the last arithmetic, logical, or data manipulation was zero.

Carry/Borrow (C) — When set, this bit indicates that a carry or borrow out of the Arithmetic Logic Unit (ALU) occurred during the last arithmetic operation. This bit is also affected during bit test and branch instructions plus shifts and rotates.

TIMER

The MC6805R2 MCU timer circuitry is shown in Figure 9. The 8-bit counter may be loaded under program control and is decremented toward zero by the clock input (or prescaler output). When the timer reaches zero, the timer interrupt request bit (bit 7) in the Timer Control Register (TCR) is set. The timer interrupt can be masked (disabled) by setting the timer interrupt mask bit (bit 6) in the TCR. The interrupt bit (I-bit) in the Condition Code Register also prevents a timer interrupt from being processed. The MCU responds to this interrupt by saving the present CPU state in the stack. fetching the timer interrupt vector from locations \$FF8 and \$FF9 and executing the interrupt routine (see the INTER-RUPT section). THE TIMER INTERRUPT REQUEST BIT MUST BE CLEARED BY SOFTWARE. The timer and INT2 share the same interrupt vector. THE INTERRUPT ROUTINE MUST CHECK THE REQUEST BITS TO DETERMINE THE SOURCE OF THE INTERRUPT

The clock input to the timer can be from an external source (decrementing of Timer Counter occurs on a positive transition of the external source) applied to the TIMER input pin, or it can be the internal $\phi 2$ signal. When the $\phi 2$ signal is used as the source, it can be gated by an input applied to the

TIMER input pin allowing the user to easily perform pulsewidth measurements. (NOTE: For ungated $\phi 2$ clock input to the timer prescaler, the TIMER pin should be tied to VCC) The source of the clock input is one of the mask options that is specified before manufacture of the MCU

A prescaler option can be applied to the clock input that extends the timing interval up to a maximum of 128 counts before decrementing the counter. This prescaling mask option is also specified before manufacture. To avoid truncation errors, the prescaler is cleared when bit 3 of Timer Control Register is written to a logic 1 (this bit always reads as a logic 0).

The timer continues to count past zero, falling through to \$FF from zero and then continuing the count. Thus, the counter can be read at any time by reading the Timer Data Register (TDR) This allows a program to determine the length of time since a timer interrupt has occurred, and not disturb the counting process.

At power-up or reset, the prescaler and counter are inintalized with all logical ones; the timer interrupt request bit (bit 7) is cleared and the timer interrupt request mask bit (bit 6) is set.

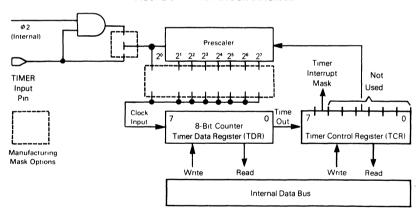


FIGURE 9 - TIMER BLOCK DIAGRAM

SELF-CHECK

The self-check capability of the MC6805R2 MCU provides an internal check to determine if the part is functional. Connect the MCU as shown in Figure 10 and monitor the output of Port C bit 3 for an oscillation of approximaty 7 Hz. A 9 volt level on the TIMER input, pin 8, energizes the ROM-based self-check feature. The self-check program exercises the RAM, ROM, timer, A/D, interrupts, and I/O ports.

Several of the self-check subroutines can be called by a user program with a JSR or BSR instruction. They are the RAM, ROM, and 4-channel A/D tests. The timer routine may also be called if the timer input is the internal \$2\$ clock.

RAM SELF-CHECK SUBROUTINE — The RAM self-check is called at location \$F6F and returns with the Z-bit

clear if any error is detected; otherwise the Z-bit is set. The walking diagnostic pattern method is used.

The RAM test must be called with the stack pointer at \$07F.When run, the test checks every RAM cell except for \$07F and \$07E which are assumed to contain the return address

The A and X registers and all RAM locations except the top two are modified

ROM CHECKSUM SUBROUTINE — The ROM self-check is called at location \$F8A and returns with the Z-bit cleared if any error was found; otherwise Z=1. X=0 on return, and A is zero if the test passed. RAM locations \$040-\$043 are overwritten.

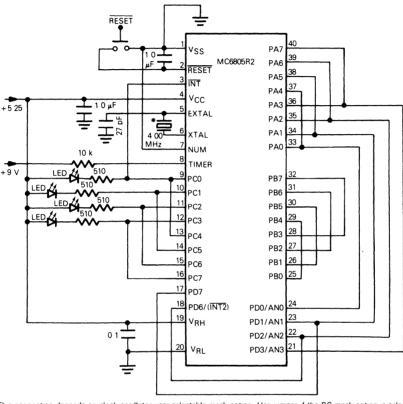


FIGURE 10 - SELF-CHECK CONNECTIONS

*This connection depends on clock oscillator user selectable mask option. Use jumper if the RC mask option is selected

LED Meanings

| | | | | | LED Meanings | | | | | | | | | | | |
|---|----|---------|-------|---|--------------------------------|--|--|--|--|--|--|--|--|--|--|--|
| | C0 | C1 | C2 | г | Remarks [1:LED ON; 0:LED OFF] | | | | | | | | | | | |
| Γ | 1 | 0 | 1 | 0 | Bad I/O | | | | | | | | | | | |
| | 0 | 0 | 1 | 0 | Bad Timer | | | | | | | | | | | |
| 1 | 1 | 1 | 0 | 0 | Bad RAM | | | | | | | | | | | |
| | 0 | 1 | 0 | 0 | Bad ROM | | | | | | | | | | | |
| | 1 | 0 | 0 | 0 | Bad A/D | | | | | | | | | | | |
| | 0 | 0 | 0 | 0 | Bad Interrupts or Request Flag | | | | | | | | | | | |
| L | | All Fla | shing | | Good Part | | | | | | | | | | | |

Anything else bad Part, Bad Port 3, Bad ISP, etc

A-TO-D CONVERTER SELF-CHECK — The A/D self-check is called at location \$FA4 and returns with the Z-bit cleared if any error was found, otherwise Z=1.

The A and X register contents are lost. The X register must be set to 4 before the call. On return X=8 and A/D channel 7 is selected. The A/D test uses the internal voltage references and confirms port connections

TIMER SELF-CHECK SUBROUTINE — The timer self-check is called at location FCF and returns with the Z-bit cleared if any error was found; otherwise Z=1.

In order to work correctly as a user subroutine, the internal $\phi 2$ clock must be the clocking source and interrupts must be disabled. Also, on exit, the clock is running and the interrupt mask not set so the caller must protect from interrupts if necessary.

The A and X register contents are lost. The timer self-check routine counts how many times the clock counts in 128 cycles. The number of counts should be a power of two since the prescaler is a power of two. If not, the timer probably is not counting correctly. The routine also detects a timer which is not running.

RESETS

The MCU can be reset three ways: by initial power-up, by the external reset input (RESET), and by an $t_{\rm CVC}$ internal low voltage detect circuit, see Figure 11. The internal circuit connected to the RESET pin consists of a Schmitt trigger which senses the RESET line logic level. The Schmitt trigger provides an internal reset voltage if it senses a logical 0 on the RESET pin. During power-up, the Schmitt trigger switches on (removes reset) when the RESET pin voltage rises to VIRES+. When the RESET pin voltage falls to a logical 0 for a period longer than one $t_{\rm CVC}$, the Schmitt trigger switches off to provide an internal reset voltage. The "switch off" voltage occurs at VIRES — A typical reset Schmitt trigger hysteresis curve is shown in Figure 12.

Upon power-up, a delay of T_{RHL} milliseconds is needed before allowing the RESET input to go high. This time allows the internal clock generator to stabilize. Connecting a capacitor to the RESET input as shown in Figure 13 typically provides sufficient delay.

INTERNAL CLOCK GENERATOR OPTIONS

The internal clock generator circuit is designed to require a minimum of external components. A crystal, a resistor, a jumper wire, or an external signal may be used to control the internal clock generator with various stability/cost tradeoffs. A manufacturing mask option is used to select the crystal or resistor option. The oscillator frequency is internally divided by four to produce the internal system clocks.

The different connection methods are shown in Figure 14
The Crystal specifications are given in Figure 15. A resistor selection graph is shown in Figure 16.

The crystal oscillator start-up time is a function of many variables crystal parameters (especially Rs) oscillator load capacitances, IC parameters, ambient temperatures, supply voltage, and supply voltage turn-on time. To ensure rapid oscillator start-up, neither the crystal characteristics nor the load capacitances should exceed recommendations.

FIGURE 11 - POWER AND RESET TIMING

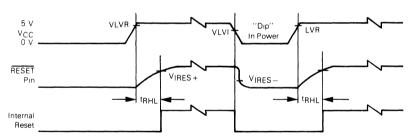


FIGURE 12 — TYPICAL RESET SCHMITT TRIGGER HYSTERESIS

Out Of Reset

Reset

0 8 V 2 V 4 V

FIGURE 13 - POWER UP RESET DELAY CIRCUIT

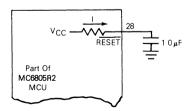
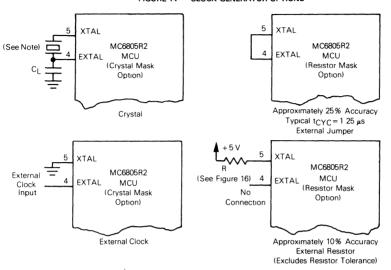
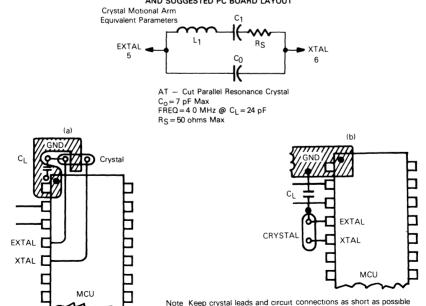


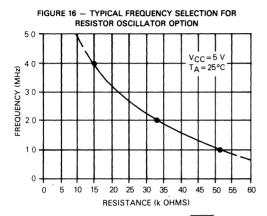
FIGURE 14 -- CLOCK GENERATOR OPTIONS



NOTE The recommended C_L value with a 4 0 MHz crytal is 27 pF, maximum, inlouding system distributed capacitance. There is an internal capacitance of approximately 25 pF on the XTAL pin. For crystal frequencies other than 4 MHz, the total capacitance on each pin should be scaled as the inverse of the frequency ratio. For example, with a 2 MHz crystal, use approximately 50 pF on XTAL. The exact value depends on the Motional-Arm parameters of the crystal used.

FIGURE 15 — CRYSTAL MOTIONAL ARM PARAMETERS AND SUGGESTED PC BOARD LAYOUT



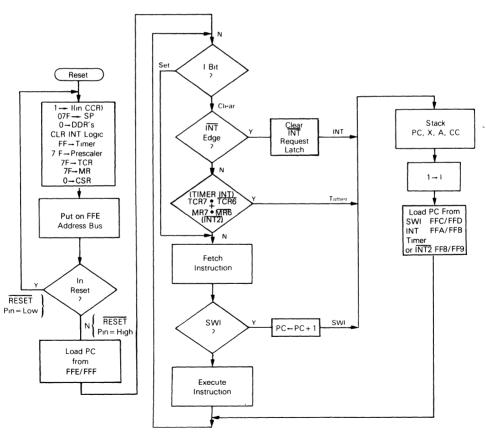


INTERRUPTS

The MC6805R2 MCU can be interrupted four different ways: through the external interrupt ($\overline{\text{INT}}$) input pin, the internal timer interrupt request, the external port D bit 6 ($\overline{\text{INT}}$) input pin, and a software interrupt instruction (SWI) When any interrupt occurs, processing is suspended, the present CPU state is pushed onto the stack, the interrupt bit (I-bit) in the Condition Code Register is set, the address of the interrupt routine is obtained from the appropriate interrupt vector address, and the interrupt routine is executed Stacking the CPU registers, setting the I-bit, and vector fetching requires a total of 11 t_{CVC} periods for completion

Refer to Figure 17 for a flowchart. The interrupt service routine must end with a Return from Interrupt (RTI) instruction which allows the MCU to resume processing of the program prior to the interrupt. Table 1 provides a listing of the interrupts, their priority, and the address of the vector which

FIGURE 17 - RESET AND INTERRUPT PROCESSING FLOWCHART



contains the starting address of the appropriate interrupt service routine. The interrupt priority applies to those pending when the CPU is ready to accept a new interrupt RESET is listed in Table 1 because it is processed similar to an interrupt. However, it is not normally used as an interrupt. When the interrupt mask bit in the Condition Code Register is set the interrupt is latched for later interrupt execution

NOTE

The timer and INT2 share the same vector address. The interrupt routine must determine the source by examining the interrupt request bits (TCR7 and MR7) Both TCR7 and MR7 can only be written to 0 by software

The external interrupts, $\overline{\text{INT}}$ and $\overline{\text{INT2}}$, are set on the falling edge of the input signal. The $\overline{\text{INT2}}$ has an interrupt request bit (bit 7) and a mask bit (bit 6) located in the

Miscellaneous Register (MR), refer to Figure 18 The $\overline{\text{INT2}}$ interrupt is inhabited when the mask bit is set The $\overline{\text{INT2}}$ is always readable as a digital input of Port D. The $\overline{\text{INT2}}$ and timer interrupt request bits, if set, causes the MCU to process an interrupt when the condition code I-bit is clear

TABLE 1 - INTERRUPT PRIORITIES

| Interrupt | Priority | Vector Address |
|------------|----------|-----------------|
| RESET | 1 | \$FFE and \$FFF |
| SWI | 2* | \$FFC and \$FFD |
| ĪNT | 3 | \$FFA and \$FFB |
| TIMER/INT2 | 4 | \$FF8 and \$FF9 |

*Priority 2 applies when the I-bit in the Condition Code Register is set When I = 0, SWI has a priority of 4, like any other instruction, the priority of INT thus becomes 2 and the timer becomes 3

FIGURE 18 - MCU REGISTER CONFIGURATION

PORT DATA DIRECTION REGISTER (DDR) PORT DATA REGISTER 0 (1) Write Only, reads as all 1's Port A Addr = \$000 Port B Addr = \$001 (2) 1 = Output, 0 = Input Cleared to 0 by Reset (3) Port A Addr = \$004 Port C Addr = \$002 Port B Addr = \$005 Port D Addr = \$003 Port C Addr = \$006 TIMER DATA REGISTER (TDR) TIMER CONTROL REGISTER (TCR) 0 MSB LSB \$008 1 1 TCR7-Timer Interrupt Request Status Bit Set when TDR goes to zero, must be cleared by software Cleared to 0 by Reset TCR6-Timer Interrupt Mask Bit 1= timer interrupt masked (disabled) Set to 1 by Reset TCR3-Clear prescaler always reads as a 0, clears prescaler when written to a logic 1 TCR Bits 5, 4, 2, 1, 0 reads 1's - unused bits MISCELLANEOUS REGISTER (MR) 6 0 1 SONA MR7 Bit 7-INT2 Interrupt Request Bit Set when falling edge detected on INT2 pin, must be cleared by software Cleared to 0 by Reset MR6 Bit 6-INT2 Interrupt Mask Bit 1=INT2 Interrupt

A/D CONTROL REGISTER (ACR)

| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | |
|---|---|---|---|---|---|---|---|-------|
| | 1 | 1 | 1 | 1 | | | | \$00E |

Bit 7—Conversion Complete Status Flag Set when conversion is complete, Cleared only on a write to ACR

Readable, not writable

Bits 2, 1, 0 — A/D input Mux Selection (See Table 2) Bits 6, 5, 4, 3 read as 1's — unused bits

masked (disabled) Set to 1 by Reset MR Bits 5, 4, 3, 2,1, 0 - Read as 1's - unused bits

A sinusoidal input signal ($f|_{NT}$ maximum) can be used to operate an external interrupt (\overline{INT}), as shown in Figure 19, for use as a Zero-Crossing Detector with hysteresis included. An interrupt request is generated for each negative-slope, zero crossing of the AC signal. For digital applications, the \overline{INT} can be driven directly by a digital signal at a maximum period of $t|_{WL}$. This allows applications such as servicing time-of-day routines and engaging/disengaging AC power control devices. Off-chip full wave rectification provides an interrupt at every zero crossing of the AC signal and thereby provide a 2f clock

A software interrupt (SWI) is an executable instruction which is executed regardless of the state of the I-bit in the Condition Code Register SWI's are usually used as breakpoints for debugging or as system calls

INPUT/OUTPUT

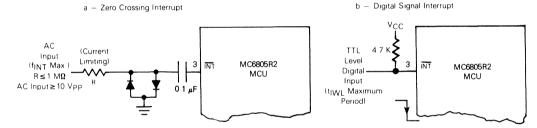
There are 30 input or input/output pins. The INT pin may also be polled with branch instructions to provide an additional input pin. All pins on ports A, B, and C are programmable as either inputs or outputs under software control of the corresponding. Data Direction Registers (DDRs). The port I/O programming is accomplished by setting the corresponding to the cor

responding bit in the port DDR to a logic "1" for output or a logic "0" for input. On reset all the DDRs are initialized to a logic "0" state, placing the ports in the input mode. The port output registers are not initialized on reset and should be initialized by software before changing the DDRs from input to output. When programmed as outputs, all I/O pins read latched output data, regardless of the logic levels at the output pin due to output loading, refer to Figure 20

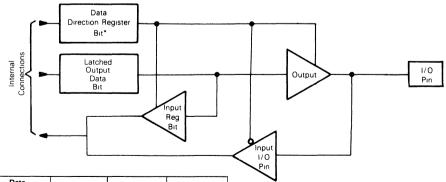
All input/output lines are TTL compatible as both inputs and outputs. Port A lines are CMOS compatible as outputs using a mask option. Port B, C, and D lines are CMOS compatible as inputs. Port D lines are input only, thus, there is no corresponding DDR. When programmed as outputs, Port B is capable of sinking 10 milliamperes and sourcing 10 milliampere on each pin.

Port D provides the multiplexed analog inputs, reference voltages, and $\overline{INT2}\,$ All of these lines are shared with the Port D digital inputs Port D may always be used as digital inputs and may also be used as analog inputs. The VRL to VRH lines (PD4 and PD5) are internally connected by the A/D resistor. Analog inputs may be pre-scaled to attain the VRL to VRH recommended input voltage range.

FIGURE 19 - TYPICAL INTERRUPT CIRCUITS







Data Direction Output Input Data Register Output To Bit Bit MCU State 0 0 0 3-State** 0 Х Pın

- *DDR is a write-only register and reads as all 1's
- **Ports A (with CMOS drive disabled), B, and C are three-state ports. Port A has optional internal pullup devices to provide CMOS drive capability. See Electrical Characteristics tables for complete information.

Figure 21 provides some examples of port connections. The Address Map in Figure 6 gives the addresses of data registers and DDRs. The Register Configuration is provided in Figure 18.

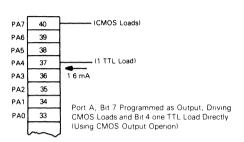
CAUTION

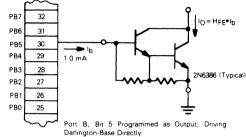
The corresponding DDRs for Ports A, B, and C are

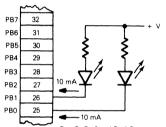
write-only registers (locations \$004, \$005, and \$006) A read operation on these registers is undefined. Since BSET and BCLR are read/modify/write functions, they cannot be used to set or clear a DDR bit (all "unaffected" bits would be set). It is recommended that all DDR bits in a port be written using a single-store instruction.

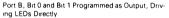
FIGURE 21 - TYPICAL PORT CONNECTIONS

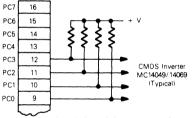
a. Output Modes





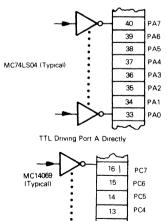


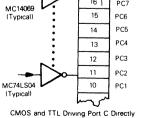


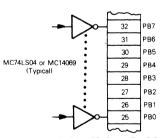


Port C, Bits 0-3 Programmed as Output, Driving CMOS Loads, Using External Pullup Resistors

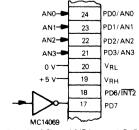
b. Input Modes







CMOS or TTL Driving Port B Directly



Port D used as 4-Channel A/D Input with Bit 7 used as CMOS Digital Input

The latched output data bit (see Figure 18) may always be written. Therefore, any write to a port writes all of its data bits even though the port DDR is set to input. This may be used to initialize the data registers and avoid undefined outputs. However, care must be exercised when using read/modify/write instructions since the data read corresponds to the pin level if the DDR is an input (0) and corresponds to the latched output data when the DDr is an output (1)

ANALOG-TO-DIGITAL CONVERTER (A/D) — The MC6805R2 MCU has an 8-bit A/D converter implemented on the chip using a successive approximation technique, as shown in Figure 22. Up to four external analog inputs, via port D, are connected to the A/D through a multiplexer Four internal analog signals may be selected for calibration purposes (VRH, VRH/2, VRH/4, VRL)

The multiplexer selection is controlled by the A/D Control Register (ACR) bits 0, 1, and 2, see Table 2. This register is cleared during any Reset condition. Refer to Figure 18 for Register Configuration

Whenever the ACR is written, the conversion in progress is aborted, the conversion complete flag (ACR bit 7) is cleared, and the selected input is sampled and held internally.

The converter operates continously using 30 machine cycles to complete a conversion of the sampled analog input When conversion is complete, the digitized sample or digital value is placed in the A/D Result Register (ARR), the conversion complete flag is set, the selected input is sampled again, and a new conversion is started.

The A/D is ratiometric. Two reference voltage (VRH and VRL) are supplied to the converter via Port D pins. An input voltage equal to VRH converts to \$FF (full scale) and an input voltage equal to VRL converts \$00. An input voltage greater than VRH converts to FF16 and no overflow indication is provided. For ratiometric conversions, the source of each analog input should use VRH as the supply voltage and be referenced to VRL.

CAUTION

This device contains circuitry to protect the inputs against damage due to high static voltages or electric field, however, the design of the input circuitry for the analog reference voltage pins (19 and 20) does not offer the SAME level of protection. Precautions should be taken to avoid applications of any voltage higher than maximum-rated voltage or handled in any environment producing high-static voltages.

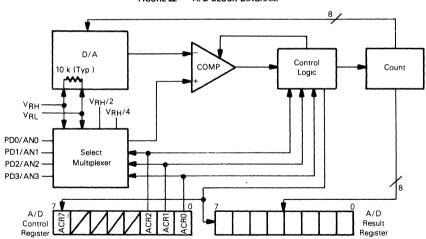


FIGURE 22 - A/D BLOCK DIAGRAM

TABLE 2 - A/D INPUT MUX SELECTION

| Α | /D Control Regist | er | Input Selected |
|-----|-------------------|-----|--|
| CR2 | CR1 | CR0 | |
| 0 | 0 | 0 | AN0 |
| 0 | 0 | 1 | AN1 |
| 0 | 1 | 0 | AN2 |
| 0 | 1 | 1 | AN3 |
| 1 | 0 | 0 | V _{RH} ≠ |
| 1 | 0 | 1 | V _{RH} * V _{RL} * |
| 1 | 1 | 0 | VRH/4* |
| 1 | 11 | 11 | V _{RH/2} ₩ |

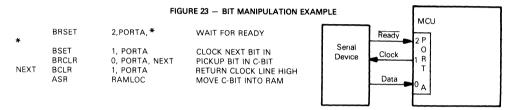
^{*}Internal (Calibration) levels

BIT MANIPULATION

The MC6805R2 MCU has the ability to set or clear any single RAM or input/output bit (except the Data Direction Registers, see Caution under INPUT/OUTPUT paragraph) with a single instruction (BRSET, BCLR). Any bit in page zero including ROM, except the DDRs, can be tested using the BRSET and BRCLR instructions and the program branches as a result of its state. The carry bit (C) equals the value of the bit referenced by BRSET or BRCLR. The capability of work with any bit in RAM, ROM, or I/O allows the user to have individual flags in RAM or to handle single

I/O bits as control lines

The coding example in Figure 23 illustrates the usefulness of the bit manipulation and test instructions. Assume that the MCU is to communicate with an external serial device. The external device has a data ready signal, a data output line, and a clock line to clock data one bit at a time, LBS first, out of the device. The MCU waits until the data is ready, clocks the external device, picks up the data in the Carry Flag (C-bit), clears the clock line and finally accumulates the data bits in a RAM location.



ADDRESSING MODES

The MC6805R2 MCU has ten addressing modes available for use by the programmer. They are explained briefly in the following paragraphs. For additional details and graphical illustrations, refer to the M6805 Family Users Manual.

The term "effective address" (EA) is used in describing the addressing modes EA is defined as the address from which the argument for an instruction is fetched or stored

IMMEDIATE — In the immediate addressing mode, the operand is contained in the byte immediately following the opcode. The immediate addressing mode is used to access constants which do not change during program execution (e.g., a constant used to initialize a loop counter).

DIRECT — In the direct addressing mode, the effective address of the argument is contained in a single byte following the opcode byte. Direct addressing allows the user to directly address the lowest 256 bytes in memory with a single 2-byte instruction. This address area includes all on-chip RAM and I/O registers and 128 bytes of ROM. Direct addressing is an effective use of both memory and time.

EXTENDED — In the extended addressing mode, the effective address of the argument is contained in the two bytes following the opcode Instructions with extended addressing mode are capable of referencing arguments anywhere in memory with a single 3-byte instruction. When using the Motorola assembler, the user need not specify whether an instruction uses direct or extended addressing. The assembler automatically selects the shortest form of the instruction.

RELATIVE — The relative addressing mode is only used in branch instructions in relative addressing, the contents of the 8-bit signed byte following the opcode (the offset) is added to the PC if, and only if, the branch condition is true Otherwise, control proceeds to the next instruction. The span of relative addressing is from ± 129 to ± 126 from the opcode address. The programmer need not worry about calculating the correct offset if he uses the Motorola assembler, since it calculates the proper offset and checks to see if it is within the span of the branch.

INDEXED, NO OFFSET — In the indexed, no offset addressing mode, the effective address of the argument is contained in the 8-bit index register. Thus, this addressing mode can access the first 256 memory locations. These instructions are only one byte long. This mode is often used to move a pointer through a table or to hold the address of a frequently referenced RAM or I/O location.

INDEXED, 8-BIT OFFSET — In the indexed, 8-bit offset addressing mode, the effective address is the sum of the contents of the unsigned 8-bit index register and the unsigned byte following the opcode. This addressing mode is useful in selecting the kth element in an nielement table. With this 2-byte instruction, k would typically be in X with the address of the beginning of the table in the instruction. As such tables may begin anywhere within the first 256 addressable locations and could extend as far as location 511 (41EE).

INDEXED, 16-BIT OFFSET — In the indexed, 16-bit offset addressing mode, the effective address is the sum of the contents of the unsigned 8-bit index register and the two unsigned bytes following the opcode. This addressing mode can be used in a manner similar to indexed, 8-bit offset except that this 3-byte instruction allows tables to be anywhere in memory. As with direct and extended, the Motorola assembler determines the shortest form of indexed addressing.

BIT SET/CLEAR — In the bit set/clear addressing mode, the bit to be set or cleared is part of the opcode, and the byte following the opcode specifies the direct address of the byte in which the specified bit is to be set or cleared. Thus, any read/write bit in the first 256 locations of memory, including 1/O, can be selectively set or cleared with a single 2-byte instruction. See Caution under INPUT/OUTPUT paragraph.

BIT TEST AND BRANCH — The bit test and branch addressing mode is a combination of direct addressing and relative addressing. The bit which is to be tested and condition (set or clear) included in the opcode, and the address of the byte to be tested is in the single byte immediately following the opcode byte. The signed relative 8-bit offset in the

third byte is added to the PC if the specified bit is set or clear in the specified memory location. This single 3-byte instruction allows the program to branch based on the condition of any readable bit in the first 256 location of memory. The span of branching is from +130 to -125 from the opcode address. The state of the tested bit is also transferred to the Carry bit of the Condition Code Registers. See Caution under INPUT/OUTPUT paragraph.

INHERENT — In the inherent addressing mode, all the information necessary to execute the instruction is contained in the opcode. Operations specifying only the index register or accumulator, as well as control instructions with no other arguments, are included in this mode. These instructions are one byte long.

INSTRUCTION SET

The MC6805R2 MCU has a set of 59 basic instructions, which when combined with the 10 addressing modes produce 207 usable opcodes. They can be divided into five different types register/memory, read/modify/write, branch, bit manipulation, and control. The following paragraphs briefly explain each type. All the instructions within a given type are presented in individual tables.

REGISTER/MEMORY INSTRUCTIONS — Most of these instructions use two operands. One operand is either the accumulator or the index register. The other operand is obtain-

ed from memory using one of the addressing modes. The jump unconditional (JMP) and jump to subroutine (JSR) instructions have no register operand. Refer to Table 3.

READ/MODIFY/WRITE INSTRUCTIONS — These instructions read a memory location or a register, modify or test its contents, and write the modified value back to memory or to the register, see Caution under INPUT/OUT-PUT paragraph. The test for negative or zero (TST) instruction is included in the read/modify/write instruction though it does not perform the write. Refer to Table 4.

BRANCH INSTRUCTIONS — The branch instructions cause a branch from the program when a certain condition is met. Refer to Table 5.

BIT MANIPULATION INSTRUCTIONS — The instructions are used on any bit in the first 256 bytes of the memory, see Caution under INPUT/OUTPUT paragraph. One group either sets or clears. The other group performs the bit test and branch operations. Refer to Table 6

CONTROL INSTRUCTION — The control instructions control the MCU operations during program execution Refer to Table 7

 $\begin{tabular}{ll} ALPHABETICAL LISTING - The complete instruction set is given in alphabetical order in Table 8 \end{tabular}$

OPCODE MAP — Table 9 is an opcode map for the instruction used on the MCU

TABLE 3 - REGISTER/MEMORY INSTRUCTIONS

| | | | | | | | | | Α | ddressin | g Mod | es | | | | | | | |
|---|----------|------------|------------------|-------------|------------|---------------------|-------------|------------|------------|-------------|------------|------------|----------------------------|------------|------------|-------------|------------|------------|-------------|
| | | | Immediate Direct | | | Indexed (No Offset) | | | | (8 | Index | | Indexed (16 Bit Offset) | | | | | | |
| Function | Mnemonic | Op Code | # Bytes | # Cycles | Op Code | # Bytes | # Cycles | Op Code | # Bytes | # Cycles | Op Code | # Bytes | # Cycles | Op Code | # Bytes | # Cycles | OP Code | # Bytes | # Cycles |
| Load A from Memory | LDA | A6 | 2 | 2 | B6 | 2 | 4 | C6 | 3 | 5 | F6 | 1 | 4 | E6 | 2 | 5 | D6 | 3 | 6 |
| Load X from Memory | LDX | AE | 2 | 2 | BE | 2 | 4 | CE | 3 | 5 | FE | 1 | 4 | EE | 2 | 5 | DE | 3 | 6 |
| Store A in Memory | STA | _ | - | | B7 | 2 | 5 | C7 | 3 | 6 | F7 | 1 | 5 | E 7 | 2 | 6 | D7 | 3 | 7 |
| Store X in Memory | STX | _ | - | | BF | 2 | 5 | CF | 3 | 6 | FF | 1 | 5 | EF | 2 | 6 | DF | 3 | 7 |
| Add Memory to A | ADD | AB | 2 | 2 | ВВ | 2 | 4 | СВ | 3 | 5 | FB | 1 | 4 | EB | 2 | 5 | DB | 3 | 6 |
| Add Memory and Carry to A | ADC | Α9 | 2 | 2 | В9 | 2 | 4 | С9 | 3 | 5 | F9 | 1 | 4 | E9 | 2 | 5 | D9 | 3 | 6 |
| Subtract Memory | SUB | A0 | 2 | 2 | во | 2 | 4 | CO | 3 | 5 | F0 | 1 | 4 | EO | 2 | 5 | D0 | 3 | 6 |
| Subtract Memory from A with Borrow | SBC | A2 | 2 | 2 | В2 | 2 | 4 | C2 | 3 | 5 | F2 | 1 | 4 | E2 | 2 | 5 | D2 | 3 | 6 |
| AND Memory to A | AND | A4 | 2 | 2 | В4 | 2 | 4 | C4 | 3 | 5 | F4 | 1 | 4 | E4 | 2 | 5 | D4 | 3 | 6 |
| OR Memory with A | ORA | AA | 2 | 2 | ВА | 2 | 4 | CA | 3 | 5 | FA | 1 | 4 | EA | 2 | 5 | DA | 3 | 6 |
| Exclusive OR Memory with A | EOR | A8 | 2 | 2 | В8 | 2 | 4 | С8 | 3 | 5 | F8 | 1 | 4 | E8 | 2 | 5 | D8 | 3 | 6 |
| Arithmetic Compare A with Memory | СМР | Α1 | 2 | 2 | В1 | 2 | 4 | C1 | 3 | 5 | F1 | 1 | 4 | E1 | 2 | 5 | D1 | 3 | 6 |
| Arithmetic Compare X with Memory | СРХ | А3 | 2 | 2 | В3 | 2 | 4 | С3 | 3 | 5 | F3 | 1 | 4 | E3 | 2 | 5 | D3 | 3 | 6 |
| Bit Test Memory with A (Logical Compare) | віт | A5 | 2 | 2 | В5 | 2 | 4 | C5 | 3 | 5 | F5 | 1 | 4 | E5 | 2 | 5 | D5 | 3 | 6 |
| Jump Unconditional | JMP | _ | - | - | BC | 2 | 3 | CC | 3 | 4 | FC | 1 | 3 | EC | 2 | 4 | DC | 3 | 5 |
| Jump to Subroutine | JSR | - | - | - | BD | 2 | 7 | CD | 3 | 8 | FD | 1 | 7 | ED | 2 | 8 | DD | 3 | 9 |

TABLE 4 - READ/MODIFY/WRITE INSTRUCTIONS

| | | | | | | | | Addr | essing | Modes | | | | | | |
|------------------------------|----------|------------|------------|-------------|------------|------------|-------------|------------|------------|-------------|------------|------------|-------------|------------|----------------|-------------|
| | | , | nheren | t (A) | lı | nheren | t (X) | | Direc | ;t | (| Index | | (8 | Index Bit O | |
| Function | Mnemonic | Op Code | # Bytes | # Cycles | Op Code | # Bytes | # Cycles | Op Code | # Bytes | # Cycles | Op Code | # Bytes | # Cycles | Op Code | # Bytes | # Cycles |
| Increment | INC | 4C | 1 | 4 | 5C | 1 | 4 | 3C | 2 | 6 | 7C | 1 | 6 | 6C | 2 | 7 |
| Decrement | DEC | 4A | 1 | 4 | 5A | 1 | 4 | 3A | 2 | 6 | 7A | 1 | 6 | 6A | 2 | 7 |
| Clear | CLR | 4F | 1 | 4 | 5F | 1 | 4 | 3F | 2 | 6 | 7F | 1 | 6 | 6F | 2 | 7 |
| Complement | сом | 43 | 1 | 4 | 53 | 1 | 4 | 33 | 2 | 6 | 73 | 1 | 6 | 63 | 2 | 7 |
| Negate (2's Complement) | NEG | 40 | 1 | 4 | 50 | 1 | 4 | 30 | 2 | 6 | 70 | 1 | 6 | 60 | 2 | 7 |
| Rotate Left Thru Carry | ROL | 49 | 1 | 4 | 59 | 1 | 4 | 39 | 2 | 6 | 79 | 1 | 6 | 69 | 2 | 7 |
| Rotate Right Thru Carry | ROR | 46 | 1 | 4 | 56 | 1 | 4 | 36 | 2 | 6 | 76 | 1 | 6 | 66 | 2 | 7 |
| Logical Shift Left | LSL | 48 | 1 | 4 | 58 | 1 | 4 | 38 | 2 | 6 | 78 | 1 | 6 | 68 | 2 | 7 |
| Logical Shift Right | LSR | 44 | 1 | 4 | 54 | 1 | 4 | 34 | 2 | 6 | 74 | 1 | 6 | 64 | 2 | 7 |
| Arithmetic Shift Right | ASR | 47 | 1 | 4 | 57 | 1 | 4 | 37 | 2 | 6 | 77 | 1 | 6 | 67 | 2 | 7 |
| Test for Negative or Zero | TST | 4D | 1 | 4 | 5D | 1 | 4 | 3D | 2 | 6 | 7D | 1 | 6 | 6D | 2 | 7 |

TABLE 5 - BRANCH INSTRUCTIONS

| | | Relative | Addressi | ng Mode |
|--|----------|----------|----------|---------|
| | | Op | # | # |
| Function | Mnemonic | Code | Bytes | Cycles |
| Branch Always | BRA | 20 | 2 | 4 |
| Branch Never | BRN | 21 | 2 | 4 |
| Branch IFF Higher | ВНІ | 22 | 2 | 4 |
| Branch IFF Lower or Same | BLS | 23 | 2 | 4 |
| Branch IFFCarry Clear | BCC | 24 | 2 | 4 |
| (BranchIFFHigher or Same) | (BHS) | 24 | 2 | 4 |
| Branch IFF Carry Set | BCS | 25 | 2 | 4 |
| (Branch/FF Lower) | (BLO) | 25 | 2 | 4 |
| Branch IFF Not Equal | BNE | 26 | 2 | 4 |
| Branch IFF Equal | BEQ | 27 | 2 | 4 |
| Branch IFF Half Carry Clear | внсс | 28 | 2 | 4 |
| Branch IFF Half Carry Set | BHCS | 29 | 2 | 4 |
| BranchiFF Plus | BPL | 2A | 2 | 4 |
| BranchIFF Minus | ВМІ | 2B | 2 | 4 |
| Branch IFF Interupt Mask Bit is Clear | вмс | 2C | 2 | 4 |
| BranchIFFInterrupt Mask Bit is Set | BMS | 2D | 2 | 4 |
| BranchIFFInterrupt Line is Low | BIL | 2E | 2 | 4 |
| Branch IFF Interrupt Line is High | він | 2F | 2 | 4 |
| Branch to Subroutine | BSR | AD | 2 | 8 |

TABLE 6 - BIT MANIPULATION INSTRUCTIONS

| | | Addressing Modes | | | | | | | | |
|---------------------------|-------------------|--------------------------------|-------|--------|------------|-------|--------|--|--|--|
| | | Bit Set/Clear Bit Test and Bra | | | | | | | | |
| | | Op | # | # | Op | # | # | | | |
| Function | Mnemonic | Code | Bytes | Cycles | Code | Bytes | Cycles | | | |
| · Branch IFF Bit n is set | BRSET n (n = 0 7) | | - | _ | 2 • n | 3 | 10 | | | |
| Branch IFF Bit n is clear | BRCLR n (n = 0 7) | _ | - | _ | 01 + 2 • n | 3 | 10 | | | |
| Set Bit n | BSET n (n = 0 7) | 10 + 2 • n | 2 | 7 | | | | | | |
| Clear bit n | BCLR n (n = 0 7) | 11 + 2 •n | 2 | 7 | _ | _ | - | | | |

TABLE 7 - CONTROL INSTRUCTIONS

| | | | Inherent | |
|--------------------------|----------|------------|------------|-------------|
| Function | Mnemonic | Op Code | # Bytes | # Cycles |
| Transfer A to X | TAX | 97 | 1 | 2 |
| Transfer X to A | TXA | 9F | 1 | 2 |
| Set Carry Bit | SEC | 99 | 1 | 2 |
| Clear Carry Bit | CLC | 98 | 1 | 2 |
| Set Interrupt Mask Bit | SEI | 9B | 1 | 2 |
| Clear Interrupt Mask Bit | CLI | 9A | 1 | 2 |
| Software Interrupt | SWI | 83 | 1 | 11 |
| Return from Subroutine | RTS | 81 | 1 | 6 |
| Return from Interrupt | RTI | 80 | 1 | 9 |
| Reset Stack Pointer | RSP | 9C | 1 | 2 |
| No-Operation | NOP | 9D | 1 | 2 |

TABLE 8 - INSTRUCTION SET

| | г | | | A | dressing | Modes | | | | | Condition Code | | | | | |
|----------|-------------|--------------|---------------------|--------------|--|------------------------|--|--|--|-------------------------|----------------|---|---------------|--------------------------------|------------|--|
| Mnemonic | Inherent | Immediate | Direct | | | Indexed (No Offset) | | Indexed (16 Bits) | | Bit Test & Branch | | | | z | С | |
| ADC | | X | × | X | | × | X | X | | | ٨ | • | ^ | ^ | ٨ | |
| ADD | | × | X | X | | × | X | X | | | \wedge | • | $\overline{}$ | 1 | ^ | |
| AND | | × | X | × | | × | X | X | | · | • | • | ^ | _ | • | |
| ASL | X | | X | | | × | X | | | | • | • | ^ | $\overline{}$ | ٨ | |
| ASR | × | | X | <u> </u> | | × | × | <u> </u> | | <u> </u> | • | • | ٨ | ^ | ^ | |
| BCC | | | | | × | | | l | | | • | • | • | • | • | |
| BCLR | | | | <u> </u> | | | | | X | | • | • | • | • | • | |
| BCS | | | | | × | | | | | | • | • | • | • | • | |
| BEQ | | | | | × | | | | | ļ | • | • | • | • | • | |
| внсс | | | | | × | | | | | | • | • | • | • | • | |
| BHCS | | ļi | | | x | | ļ | | | <u> </u> | • | • | • | • | • | |
| BHI | | | | | X | | | | | | • | • | • | • | • | |
| BHS | | | | | × | <u> </u> | | | | | • | • | • | • | • | |
| BIH | | | | | × | | ļ | | | | • | • | • | • | • | |
| BIL | | | | | × | | | | | | ₩ | _ | | | | |
| BIT | | · X | X | × | <u> </u> | × | × | × | | <u> </u> | • | • | • | • | • | |
| | | | | | | | <u> </u> | | | ļ | | • | ^ | ^ | • | |
| BLO | | | | ļ | X | ļ | <u> </u> | | | L | • | • | • | • | • | |
| BLS | | | | | X | ļ | | ļ | | | • | • | • | • | • | |
| ВМС | | | · | | X | | ļ | | | | • | • | • | • | • | |
| ВМІ | | | | | | | | | | | • | • | • | • | • | |
| BMS | | | | | | | | | | | • | • | • | • | • | |
| BNE | | | | | | | | | | | • | • | • | • | • | |
| BPL | | | | | | i | | | | | • | • | • | • | • | |
| BRA | | | | | | | | | | | • | • | • | • | • | |
| BRN | | | | | | | | | | | • | • | • | • | • | |
| BRCLR | | | | | | | | | | X | • | • | • | • | ٨ | |
| BRSET | | 1 | | | | | | | | Х | • | • | • | • | ٨ | |
| BSET | | | | | | | | 1 | × | | • | • | • | • | • | |
| BSR | | | | | X | | | | | | • | • | • | | • | |
| CLL | X | | | | | | | | | | • | • | • | • | 0 | |
| CLI | Х | | | | | | | | | | • | 0 | • | • | • | |
| CLR | X | | X | | | X | X | | | | • | • | 0 | 1 | • | |
| CMP | | × | Х | X | | × | X | X | | | • | • | ^ | ٨ | ^ | |
| сом | X | | Х | | | × | X | <u> </u> | | | • | • | ^ | ^ | 1 | |
| CPX | | × | X | × | | × | X | X | | | • | • | _ | 1 | ٨ | |
| DEC | X | | X | | | × | × | | | | • | • | 7 | <u>\(\)</u> | • | |
| EOR | <u> </u> | X | X | X | | × | × | × | | | • | • | \ <u>\</u> | <u>\(\) \(\) \(\) \(\)</u> | • | |
| INC | X | <u>-</u> | X | | | X | X | | | | - | • | \ | \ | • | |
| JMP | | | × | × | | X | × | × | | | • | • | • | • | • | |
| JSR | | | × | x . | | × | \ x | \ x | | | • | - | • | • | - | |
| LDA | | × | $\frac{\hat{x}}{x}$ | - x | | l x | - | \ | | | - | • | × | , | • | |
| LDX | | × | × | × | | - | | × | | | - | • | Ĥ | 厼 | - | |
| | | | - x | <u> </u> | | \ | × | <u> </u> | <u> </u> | | 1 | _ | | | | |
| LSL | X | ļ | X | ļ | | 1 . | | } | | ļ | • | • | ^ | ^ | 1 | |
| LSR | X | | | | | X | X | <u> </u> | | | • | • | ļ. | <u>^</u> | <u> ^</u> | |
| NEQ | X | | Х | | | X | × | ļ | | | • | • | ^ | Λ | ^ | |
| NOP | X | ļ | | | | ļ | | | | | • | • | • | • | • | |
| ORA | | Х | Х | X | | X | × | × | <u> </u> | | • | • | ^ | ^ | • | |
| ROL | X | | X | | | Х | X | | | | • | • | ^ | ^ | ^ | |
| RSP | X | | | | | | |] | (| | • | • | • | • | • | |

Condition Code Symbols

- H Half Carry (From Bit 3)
- I Interrupt Mask
- N Negative (Sign Bit)
 Z Zero

- C Carry/Borrow
 Λ Test and Set if True, Cleared Otherwise
- Not Affected

TABLE 8 - INSTRUCTION SET (CONTINUED)

| | | | | A | ddressing | Modes | | | | | Co | nd | itio | n C | ode |
|----------|----------|--|--------|----------|-----------|------------------------|----------|----------------------|----------|-------------------------|----|----|---------------|-----|-----|
| Mnemonic | Inherent | Immediate | Direct | Extended | Relative | Indexed (No Offset) | | Indexed (16 Bits) | | Bit Test & Branch | н | , | Z | z | С |
| RTI | Х | | | | | | | | | | ? | ? | ? | ? | ? |
| RTS | X | | | | | · | | | | | • | • | • | • | • |
| SBC | | × | Х | Х | | X | X | X | | | • | • | Λ | ^ | ٨ |
| SEC | X | | | | | | <u> </u> | | | | • | • | • | • | 1 |
| SEI | X | | | | | | | | | | • | 1 | • | • | • |
| STA | | 1 | Х | Х | | X | X | X | | | • | • | ^ | ^ | • |
| STX | | | Х | Х | | × | × | X | | | • | • | ^ | ^ | • |
| SUB | | х | Х | Х | | X | X | Х | | | • | • | ٨ | ^ | ٨ |
| SWI | Х | | | | | | | | | | • | 1 | • | • | • |
| TAX | Х | | | | | | | | | | • | • | • | • | • |
| TST | X | | X | <u> </u> | | X | X | | | <u> </u> | • | • | $\overline{}$ | ^ | • |
| TXA | X | | | | | | | | | | • | • | • | • | • |

Condition Code Symbols

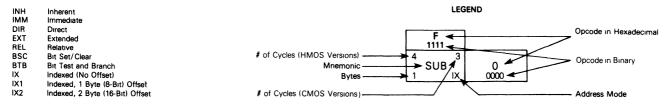
- H Half Carry (From Bit 3)
- I Interrupt Mask
- N Negative (Sign Bit)
 Z Zero

- C Carry/Borrow
- A Test and Set if True, Cleared Otherwise
- Not Affected
- 2 Load CC Register From Stack

TABLE 8 - M6805 FAMILY OPCODE MAP

| | Bit Mar | ipulation | Branch | | Re | ad/Modify/\ | Vrite | | Con | troi | | | Registe | r/Memory | | | |
|-----------|-------------------------|----------------------------------|---------------|-----------------------|----------------------|------------------------|---------------------|----------------|-----------------------|--------------|----------------|-----------------------|-----------------------|----------------|--------------|------------|-----------|
| | BTB | BSC | REL | DIR | INH(A) | INH(X) | IX1 | IX | INH | INH | IMM | DIR | EXT | IX2 | IX1 | IX | |
| Low | 0000 | 1 0001 | 2 0010 | 3 0011 | 4 0100 | 5 0101 | 6 0110 | 7 0111 | 8 1000 | 9 1001 | A 1010 | B 1011 | C 1100 | D 1101 | E 1110 | F 1111 | HI LOW |
| 0000 | BRSETO 3 BTB | BSET0 2 BSC | BRA 2 REL | 6 NEG 2 DIR | 4 NEGA 1 INH | 4 3 NEGX 1 INH | 7 NEG 6 2 IX1 | 6 NEG 5 | RTI 1 INH | | SUB 2 IMM | 4 SUB 2 DIR | SUB 3 EXT | SUB 3 IX2 | SUB IX1 | SUB 3 | 0 |
| 1 0001 | BRCLRO 3 BTB | 7 BCLR0 2 BSC | BRN 2 REL | | | A. Carrier | | | 6 RTS 1 INH | | 2 CMP 2 IMM | CMP DIR | 5 CMP 3 EXT | CMP 3 IX2 | CMP 2 IX1 | 4 CMP IX | 1 0001 |
| 2 0010 | BRSET1 3 BTB | 7 5 BSET1 2 BSC | BHI 2 REL | | | | | | | | SBC 2 IMM | SBC DIR | SBC 3 EXT | 6 SBC 3 IX2 | SBC IX1 | SBC 3 | 2 0010 |
| 3 0011 | BRCLR1 3 BTB | BCLR1 2 BSC | BLS 2 REL | 6 COM 2 DIR | COMA 1 INH | 4 COMX 3 | COM 2 IX1 | COM | 11 10 SWI 1 INH | | CPX 2 IMM | CPX DIR | CPX 3 EXT | CPX 3 IX2 | CPX 2 IX1 | 4 CPX 3 | 3 0011 |
| 4 0100 | BRSET2 3 BTB | 7 BSET2 2 BSC | BCC 2 REL | 6 LSR 2 DIR | 4 3 LSRA 1 INH | 4 SRX 1 INH | 7 6 LSR 2 IX1 | 6 LSR 1 IX | | | 2 AND 2 IMM | AND DIR | 5 AND 3 EXT | AND 3 IX2 | AND 2 IX1 | 4 AND 3 | 4 0100 |
| 5 0101 | BRCLR2 3 BTB | BCLR2 BSC | BCS 2 REL | | | | | | | | BIT 2 | BIT 2 DIR | BIT 3 EXT | 6 BIT 3 IX2 | BIT 2 IX1 | BIT 1 1X | 5 0101 |
| 6 0110 | 10 5 BRSET3 3 BTB | BSET3 | BNE 2 REL 3 | ROR | RORA 3 | 4 RORX 3 | 7 ROR 6 | 6 ROR 5 | | | LDA 2 | 4 3 LDA 2 DIR | 5 LDA 3 EXT | 6 LDA 3 IX2 | LDA 2IX1 | LDA 3 | 6 0110 |
| 7 0111 | BRCLR3 | BCLR3 | BEQ REL | ASR DIR | ASRA 1 INH | ASRX 1 INH | ASR 2 IX1 | ASR 1 IX | | TAX | 2 2 | STA DIR | STA 3 EXT | STA X2 | STA 2 1X1 | STA IX | 7 0111 |
| 8 | BRSET4 3 BTB | BSET4 BSC | BHCC REL | LSL DIR | LSLA 1 INH | LSLX 1 INH | 7 LSL 2 IX1 | LSL IX | | CLC 2 | EOR 2 IMM | EOR DIR | EOR 3 EXT | EOR 3 | EOR IX1 | EOR X | 8 1000 |
| 9 | 10 5 BRCLR4 3 BTB | 7 BCLR4 2 BSC 7 | BHCS 2 REL | 6 ROL 2 DIR 6 5 | ROLA 1 INH | ROLX 1 INH | 7 ROL 6 2 IX1 6 | 6 ROL 1 IX 6 5 | | SEC 1 INH | | ADC 2 DIR | 5 ADC 3 EXT | 6 ADC 3 IX2 | ADC IX1 | ADC IX | 9 1001 |
| A 1010 | BRSET5 3 BTB | BSET5 5 2 BSC 5 | BPL 2 REL | DEC DIR | DECA 1 INH | DECX 1 INH | DEC 1X1 | 6 DEC 1 IX | | CLI 1 INH | ORA 2 IMM | 4 ORA 2 DIR 4 3 | ORA 3 EXT | ORA 3 IX2 | ORA 2 IX1 | ORA X | A 1010 |
| B 1011 | BRCLR5 | BCLR5 2 BSC | BMI 2 REL | 6 5 | , , | 4 - 3 | 7 | | | SEI 1 INH | ADD 2 | ADD 2 DIR | ADD 3 EXT | ADD 3 IX2 | ADD 1X1 | ADD X | B 1011 |
| C 1100 | BRSET6 3 BTB | 7 BSET6 2 BSC 7 5 | BMC 2 REL | 6 INC 2 DIR 6 4 | INCA 1 INH 4 3 | 4 INCX 1 INH 4 3 | INC 2 IX1 | INC 1 IX | | RSP 1 INH | | JMP 2 DIR | 3 JMP 3 EXT | 5 JMP 3 IX2 | JMP 2 IX1 | 3 JMP 1 IX | C 1100 |
| D 1101 | BRCLR6 3 BTB | BCLR6 BSC 5 | BMS 2 REL | TST DIR | TSTA 3 | 4 TSTX 1 INH | 7 TST 5 2 IX1 | 6 TST 1X | | NOP 1 INH | BSR EL | JSR 2 DIR | JSR 3 EXT | 9 JSR 3 IX2 | JSR 2 IX1 | JSR 5 | D 1101 |
| E 1110 | BRSET7 3 BTB | BSET7 BSC 5 | BIL 2 REL | 6 5 | 4 | 4 3 | 7 6 | 6 5 | STOP 2 | 2 2 | | LDX 2 DIR | 5 LDX 3 EXT 6 5 | LDX 3 IX2 | 5 LDX 2 IX1 | 1 LDX | E 1110 |
| F 1111 | BRCLR7 3 BTB | BCLR7 BSC | BIH 2 REL | CLR DIR | CLRA 1 INH | CLRX 1 INH | CLR 1X1 | CLR | WAIT 1 INH | TXA 1 INH | | STX DIR | STX 3 EXT | STX SIX2 | STX 1X1 | STX 1 | F 1111 |

Abbreviations for Address Modes



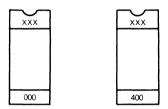
^{*}CMOS Versions only

ORDERING INFORMATION

The information required when ordering a custom MCU is listed below. The ROM program may be transmitted to Motorola on EPROM(s) or an MDOS disk file.

To initiate a ROM pattern for the MCU it is necessary to first contact you local Motorola representative or Motorola distributor

EPROMs — The MCM2716 or MCM2532 type EPROMs, programmed with the customer program (positive logic sense for address and data), may be submitted for pattern generation. The EPROM must be clearly marked to indicate which EPROM corresponds to which address space. The recommended marking procedure is illustrated below.



XXX = Customer ID

After the EPROM(s) are marked they should be placed in conductive IC carriers and securely packed. Do not use styroforam

VERIFICATION MEDIA

All original pattern media (EPROMs or Floppy Disk) are filed for contractual purposes and are not returned. A computer listing of the ROM code will be generated and returned along with a listing verification form. The listing should be

thoroughly checked and the verification form completed, signed, and returned to Motorola. The signed verification form constitutes the contractual agreement for creation of the customer mask. If desired, Motorola will program one blank EPROM from the data file used to create the custom mask to aid in the verification process.

ROM VERIFICATION UNITS (RVUs)

Ten MCUs containing the customer's ROM pattern will be sent for program verification. These units will have been made using the custom mask but are for the purpose of ROM verification only. For expediency they are usually unmarked, packaged in ceramic, and tested only at room temperature and 5 volts. These RVUs are included in the mask charge and are not production parts. The RVUs are thus not guaranteed by Motorola Quality Assurance, and should be discarded after verification is completed.

FLEXIBLE DISKS

The disk media submitted must be single-sided, single-density, 8-inch, MDOS compatible floppies. The customer must write the binary file name and company name on the disk with a felt-tip pen. The minimum MDOS system files as well as the absolute binary object file (filename. LO type of file) from the M6805 cross assembler must be on the disk. An object file made from a memory dump using the ROLLOUT command is also acceptable. Consider submitting a source listing as well as the following files filename. LX (EXOR-ciser® loadable format) and filename. SA (ASCII Source Code). These files will of course be kept confidential and are used 1) to speed up the process in-house if any problems arise, and 2) to speed up the user-to-factory interface if the user finds any software errors and needs assistance quickly from Motorola factory representatives.

MDOS is Motorola's Disk Operating System available on development systems such as EXORcisers, EXORsets, etc

MC6805R2 MCU ORDERING INFORMATION

| Customer Company | |
|---|--|
| Address | MC SC |
| CityState | Zıp |
| Country | |
| PhoneExtens | sion |
| Customer Contact Person | |
| Customer Part Number | |
| OPTION LIST | |
| Select the options for your | MCU from the following list A generated from this information |
| Timer Clock Source ☐ Internal φ2 clock ☐ TIMER input pin | |
| Timer Prescaler 2º (divide by 1) 2¹ (divide by 2) 2² (divide by 4) 2³ (divide by 8) | ☐ 2⁴ (divide by 16) ☐ 2⁵ (divide by 32) ☐ 2⁵ (divide by 64) ☐ 2² (divide by 128) |
| Internal Oscillator Input Crystal Resistor | Port A Output Drive CMOS and TTL TTL Only |
| Low Voltage Inhibit Disable Enable | |
| Pattern Media (All other media requires prior factor | · · · · |
| ☐ EPROMs (MCM2716 or MCM2 | □ Floppy Disk □ Other |
| Clad. Fare | |
| Clock Freq | to +70°C (Standard) |
| Requires prior factory approval | 10 - 70 C (Standard) |
| Marking Information (12 Characters Maximum) | |
| | |
| | |



MC6805T2

Advance Information

8-BIT MICROCOMPUTER UNIT WITH PLL LOGIC

The MC6805T2 Microcomputer Unit (MCU) with PLL logic is a member of the M6805 Family of low-cost single-chip microcomputers. This 8-bit microcomputer contains a CPU, on-chip CLOCK, ROM, RAM, I/O, TIMER, and the PLL logic for an RF synthesizer. It is designed for the user who needs an economical microcomputer with the proven capabilities of the M6800-based instruction set, as well as the necessary logic required for frequency synthesis applications. A comparison of the key features of several members of the M6805 Family of microcomputers is shown on the last page of this data sheet. The following are some of the hardware and software highlights of the MC6805T2 MCU.

HARDWARE FEATURES:

- 8-Bit Architecture
- 64 Bytes of RAM
- Memory Mapped I/O
- 2508 Bytes of User ROM
- Timer Start/Stop and Source Select
- 19 TTL/CMOS Compatible Bidirectional I/O Lines (8 Lines are LED Compatible)
- On-Chip Clock Generator
- Zero-Crossing Detection
- Self-Check Mode
- Master Reset
- Complete Development System Support on EXORciser®
- 5 V Single Supply
- 14-Bit Binary Variable Divider
- 10-Stage Mask-Programmable Reference Divider
- Three-State Phase and Frequency Comparator
- Suitable for TV Frequency Synthesizers

SOFTWARE FEATURES:

- Similar to M6800
- Byte Efficient Instruction Set
- Easy to Program
- True Bit Manipulation
- Bit Test and Branch Instructions
- Versatile Interrupt Handling
- Versatile Index Register
- Powerful Indexed Addressing for Tables
- Full Set of Conditional Branches
- Memory Usable as Registers/Flags
- Single Instruction Memory Examine/Change
- 10 Powerful Addressing Modes
- All Addressing Modes Apply to ROM, RAM, and I/O

USER SELECTABLE OPTIONS:

- Internal 8-Bit Timer with Selectable Clock Source (External Timer Input or Internal Machine Clock)
- Timer Prescaler Option (7 Bits 2^N)
- 8 Bidirectional I/O Lines with TTL or TTL/CMOS Interface Option
- 4 Vectored Interrupts; Timer, Software, and 2 External

HMOS

(HIGH DENSITY
N-CHANNEL, SILICON-GATE
DEPLETION LOAD)

8-BIT MICROCOMPUTER WITH PLL LOGIC



P SUFFIX PLASTIC PACKAGE CASE 710

FIGURE 1 - PIN ASSIGNMENTS 28 RESET vss 4 INT D 27 D PA7 26 D PA6 vcc 4 EXTAL # 4 25 D PA5 XTAL [24 D PA4 23 PA3 NUM **d** φCOMP d 22 PA2 PCO/TIMER d 8 21 h PA1 PC1 d 20 D PA0 PC2 19 PB7 f_{in} **d** 11 18 T PB6 17 🗖 PB5 PB0 1 12 16 **1** PB4 PB1 **[** 13 PB2 15 h PB3

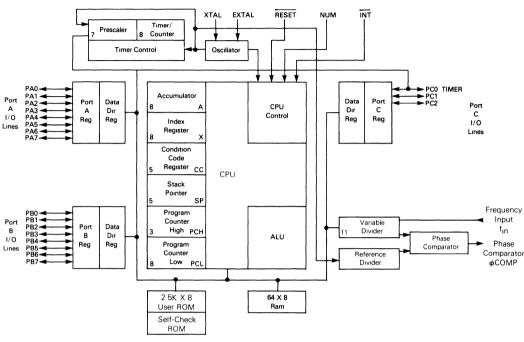


FIGURE 2 - MC6805T2 HMOS MICROCOMPUTER BLOCK DIAGRAM

MAXIMUM RATINGS

| Rating | Symbol | Value | Unit |
|-----------------------------|------------------|----------------|------|
| Supply Voltage | Vcc | -0.3 to +7.0 | V |
| Input Voltage | V _{in} | -0.3 to +7.0 | V |
| Operating Temperature Range | TA | 0 to +70 | °C |
| Storage Temperature Range | T _{stg} | -55 to +150 | °C |

THERMAL CHARACTERISTICS

| Characteristic | Symbol | Value | Unit |
|--------------------|---------------|-------|------|
| Thermal Resistance | | | |
| Plastic | | 120 | 1 |
| Ceramic | θ_{JA} | 50 | °C/W |
| Cerdip | | 60 | |

This device contains circuitry to protect the inputs against damage due to high static voltages or electric fields, however, it is advised that normal precautions be taken to avoid application of any voltage higher than maximum rated voltages to this high-impedance circuit. For proper operation it is recommended that V_{in} and V_{out} be constrained to the range $V_{SS} \leq (V_{in} \text{ or } V_{out}) \leq V_{CC}$. Reliability of operation is enhanced if unused inputs are tied to an appropriate logic voltage level (e.g., either V_{SS} or V_{CC})

POWER CONSIDERATIONS

The average chip-junction temperature, T_J, in °C can be obtained from

$$T_{J} = T_{A} + (P_{D} \bullet \theta_{JA}) \tag{1}$$

Where

TA = Ambient Temperature, °C

 θ JA = Package Thermal Resistance, Junction-to-Ambient, °C/W

PD≡PINT+PPORT

 $P_{INT} = I_{CC} \times V_{CC}$, Watts - Chip Internal Power

PPORT ■ Port Power Dissipation, Watts — User Determined

For most applications PPORT≪PINT and can be neglected PPORT may become significant if the device is configured to drive Darlington bases or sink LED loads

An approximate relationship between \mbox{PD} and $\mbox{T}_{\mbox{\scriptsize J}}$ (if $\mbox{\scriptsize PPORT}$ is neglected) is

$$P_D = K + (T_J + 273 °C)$$
 (2)

Solving equations 1 and 2 for K gives.

$$K = P_D \bullet (T_A + 273 \circ C) + \theta_{JA} \bullet P_D^2$$
(3)

Where K is a constant pertaining to the particular part. K can be determined from equation 3 by measuring PD (at equilibrium) for a known TA. Using this value of K the values of PD and TJ can be obtained by solving equations (1) and (2) iteratively for any value of TA.

SWITCHING CHARACTERISTICS ($V_{CC} = 5.25 \text{ Vdc} \pm 0.5 \text{ Vdc}$, $V_{SS} = \text{GND}$, $T_A = 0$ to 70°C unless otherwise noted)

| Characteristics | Symbol | Min | Тур | Max | Unit |
|---|-----------------|------------------------|-----|-----|------|
| Oscillator Frequency | fosc | 0 4 | - | 4 2 | MHz |
| Cycle Time (4/f _{OSC}) | tcyc | 0 95 | _ | 10 | μΑ |
| INT and TIMER Pulse Width | tWH,tWL | t _{cyc} + 250 | _ | _ | ns |
| RESET Pulse Width | tRWL | t _{cyc} + 250 | _ | _ | ns |
| RESET Delay Time (External Capacitance = 1 0 μF) | tRHL | - | 100 | _ | ms |
| Input Frequency | f _{in} | 1 | _ | 16 | MHz |
| Input Frequency Rise Time at fin | tINR | - | - | 20 | ns |
| Input Frequency Fall Time at f _{in} | tine | _ | _ | 20 | ns |
| Duty Cycle of f _{In} and External Input on EXTAL | _ | 40 | - | 60 | % |
| Injection Pulse Active Time | tarr | - | 70 | - | ns |
| INT Zero-Crossing Detection Input Frequency (for ±5° Accuracy | fINT | 0 03 | - | 10 | kHz |

ELECTRICAL CHARACTERISTICS ($V_{CC} = 5.25 \text{ Vdc} \pm 0.5 \text{ Vdc}$, $V_{SS} = \text{GND}$, $T_A = 0$ to 70°C unless otherwise noted)

| Characteristic | Symbol | Min | Тур | Max | Unit |
|--|-----------------|--|-----------------------------|---------------------------------|---------------------|
| Input High Voltage RESET (4 75≤V _{CC} ≤5 75) (V _{CC} <4 75) INT (4 75≤V _{CC} ≤5 75) (V _{CC} <4 75) All Other Except f _{in} | V _{IH} | 40 V _{CC} -05 40 V _{CC} -05 20 | - • • | Vcc Vcc Vcc Vcc Vcc | V |
| Input High Voltage ¢COMP Normal Mode Self-Check Mode | V _{IH} | _ | - 90 | V _{CC} 15 0 | ٧ |
| Input Low Voltage RESET INT All Other Except f _{In} | VIL | -03 -03 -03 | - - | 0 8 1 5 0 8 | v |
| INT Zero-Crossing Input Voltage, through a Capacitor | VINT | 20 | _ | 4 0 | V _{ac p-p} |
| Internal Power Dissipation — No Port Loading, VCC=5 75 V, TA=0°C | PINT | _ | 400 | _ | mW |
| Input Capacitance EXTAL All Others | C _{ID} | | 25 10 | _ | ρF |
| AC Coupled Input Voltage Swing | VFIP | 0.5 | 12 | _ | V _{ac p-p} |
| Input Current (V _{IH} =V _{CC}) | I _{FH} | _ | _ | 40 | μA |
| Ouput Low Current (VOL = 1 0 V) | ICML | _ | 300 | _ | μА |
| Output High Current (VOH=VCC-1 V) | ICMH | _ | 200 | _ | μА |
| Leakage Current (V _{In} = V _{CC}) | OFF | | 2 | | nA |
| RESET Hysteresis Voltage (See Figures 11 and 12) "Out of Reset" "Into Reset" | VIRES+ | 2 1 0 8 | | 4 0 2 0 | V |
| Input Current TIMER (V _{IN} = 0 4 V) INT (V _{IN} = 0 4 V) EXTAL (V _{IN} = 2 4 V to V _{CC} Crystal Option) • (V _{IN} = 0 4 V Crystal Option) RESET (V _{IN} = 0 8 V) (External Capacitor Charging Current) | l _{IN} | - - - -40 | _ 20 _ _ _ _ | 20 50 10 1600 50 | μΑ |

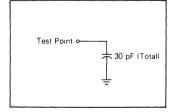
^{*}Due to internal biasing, this input (when unused) floats to approximately 2 0 V

 $\textbf{PORT ELECTRICAL CHARACTERISTICS} \ (V_{CC} = +5.25 \ \text{Vdc} \ \pm 0.5 \ \text{Vdc}, \ V_{SS} = \text{GND}, \ T_{A} = 0^{\circ} \ \text{to} \ 70^{\circ}\text{C} \ \text{unless otherwise noted} \ \text{Constant of the transfer of the tran$

| Characteristic | Symbol | Mın | Тур | Max | Unit |
|--|------------------------|-----|-----|------|------|
| Port A with CN | IOS Drive Enabled | | | | |
| Output Low Voltage, I _{Load} = 1 6 mA | V _{OL} | - | - | 0.4 | ٧ |
| Output High Voltage, I _{LOad} = -100 μA | Voн | 2 4 | | | V |
| Output High Voltage, $I_{Load} = -10 \mu A$ | Voн | 3 5 | - | - | V |
| Input High Voltage, $I_{Load} = -300 \mu A \text{ (max)}$ | V _{1H} | 2 0 | _ | Vcc | V |
| Input Low Voltate, ILoad = -500 µA (max) | VIL | 03 | _ | 0.8 | V |
| Hi-Z State Input Current (V _{IN} = 2 0 V to V _{CC}) | liн li | - | - | -300 | μΑ |
| Hi-Z State Input Current (V _{IN} =0 4 V) | li L | _ | _ | -500 | μΑ |
| Po | ort B | | | | |
| Output Low Voltage, I _{Load} = 3 2 mA | VOL | | _ | 0.4 | V |
| Output Low Voltage, I _{Load} = 10 mA (sink) | V _{OL} | _ | _ | 10 | V |
| Output High Voltage, I _{Load} = -200 μA | Voн | 2 4 | _ | _ | V |
| Darlington Current Drive (Source), VO = 15 V | 'он | -10 | _ | -10 | mΑ |
| Input High Voltage | V _{IH} | 2 0 | - | Vcc | V |
| Input Low Voltage | V _{IL} | 0 3 | _ | 0.8 | V |
| Hi-Z State Input Current | ^I TSI | _ | 2 | 20 | μА |
| Port C and Port A wit | th CMOS Drive Disabled | | | | |
| Output Low Voltage, ILoad = 1 6 mA | V _{OL} | - | _ | 0.4 | V |
| Output High Voltage, I _{Load} = -100 μA | Voн | 2 4 | - | - | V |
| Input High Voltage | V _{IH} | 2 0 | _ | Vcc | V |
| Input Low Voltage | VIL | 03 | | 0.8 | V |
| Hı-Z State Input Current | ^I TSI | _ | 2 | 20 | μΑ |

FIGURE 3 — TTL EQUIVALENT TEST LOAD FIGURE 4 — CMOS EQUIVALENT TEST LOAD (PORT A)

Test MMD6150 or Equiv $1.5 \text{ k}\Omega$ 40 pF $1.25 \text{ k}\Omega$ MMD7000 or Equiv $1.5 \text{ k}\Omega$ C = 40 pF (Total)



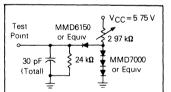


FIGURE 5 - TTL EQUIVALENT TEST LOAD

(PORTS A AND C)

SIGNAL DESCRIPTION

The input and output signals for the MCU, shown in Figure 1, are described in the following paragraphs

 \mbox{VCC} AND \mbox{VSS} — Power is supplied to the MCU using these two pins $\mbox{ VCC}$ is power and \mbox{VSS} is the ground connection

 $\overline{\text{INT}}$ — This pin provides the capability for asynchronously applying an external interrupt to the MCU Refer to INTER-RUPTS for additional information.

XTAL AND EXTAL — These pins provide control input for the on-chip clock oscillator circuit. A crystal or an external signal can be connected to these pins to provide the internal

oscillator Lead length and stray capacitance on these two pins should be minimized Refer to INTERNAL OSCILLATOR for recommendations about these pins

 $f_{\mbox{\scriptsize in}}$ — The high frequency digital input to the variable divider portion of the on-chip frequency synthesizer is on the $f_{\mbox{\scriptsize in}}$ pin. The reference frequency for the phase lock loop is divided down from the crystal oscillator. Refer to the PHASE LOCK LOOP section for details on the frequency synthesizer features.

 ϕ COMP — This three-state output is the result of comparing the internal reference frequency to the variable divider signal Refer to PLL for details In Self-Check, ϕ COMP is raised to ≈9 V

RESET - This pin allows resetting of the MCU at times other than the automatic resetting capability already in the MCU. Refer to RESETS for additional information

NUM - This pin is not for user application and must be connected to Vss.

INPUT/OUTPUT LINES (PA0-PA7, PB0-PB7, PC0-PC2)

 These 19 lines are arranged into two 8-bit ports (A and B) and one 3-bit port (C). All lines are programmable as either inputs or outputs under software control of the data direction registers. Refer to INPUT/OUTPUTS for additional information The PCO/TIMER pin also serves as an external input to the internal timer. Refer to the TIMER section for information on the timer modes

MEMORY

The MCU memory is configured as shown in Figure 6. The MCU is capable of addressing 4096 bytes of memory and I/O registers with its program counter. The MCU has implemented 2698 of these memory locations This consists of. 2508 bytes user ROM, 116 bytes self-check ROM, 64 bytes of user RAM, 6 bytes of port I/O, 2 timer registers, and 2 PLL registers The user ROM is split into four areas. The first area begins at memory location \$080, which allows the user to access ROM locations utilizing the direct and table look-up indexed addressing modes. The second user ROM area begins at memory location \$100. The last eight user ROM locations, at the top of memory, are for the interrupt vectors

The MCU reserves the first 16 memory locations for I/O features, of which 10 have been implemented. These locations are used for the ports, the port DDRs, the timer, and the PLL registers.

Sixty-four bytes of user RAM are provided Of the 64 bytes, 31 bytes are shared with the stack area. The stack must be used with care when data shares the stack area

The shared stack area is used during the processing of interrupt and subroutine calls to save the processor state

The register contents are pushed onto the stack in the order shown in Figure 7. Since the stack pointer decrements during pushes, the low order byte (PCL) of the program counter is stacked first, then the high order four bits (PCH) are stacked. This ensures that the program counter is loaded correctly following pulls from the stack, since the stack pointer increments when it pulls data from the stack A subroutine call results in only the program counter (PCH, PCL) contents being pushed onto the stack, the remaining CPU registers are not pushed.

REGISTERS

The MCU has five registers available to the programmer They are shown in Figure 8 and are explained in the following paragraphs

ACCUMULATOR (A) - The accumulator is a general purpose 8-bit register used to hold operands and results of arithmetic calculations or data manipulations

\$000

\$001

\$00C

\$03F

\$040

\$07F

0 Port A I/O Ports, RAM \$000 Page Zero PLL, Timer Port B 1 Access with 127 \$07F Short 128 \$080 Page Zero 2 1 1 1 Port C Instructions User ROM (128 bytes) 3 NOT USED 255 SOFF 256 \$100 4 Port A DDR User ROM (1792 bytes) 5 Port B DDR 2047 \$7FF

(580 bytes)

Self-Check

ROM (116 bytes)

Interrupt Vectors (8 bytes)

3971

3972

4087

4088

4095

\$002 \$003 \$004* \$005* 2048 \$800 NOT USED 6 Port C DDR \$006* NOT USED 7 \$007 Not Used 8 Timer Data Register \$008 (1344 bytes) 9 Timer Control Register \$009 10 Variable Divider LSB \$00A 3391 \$D3F 3392 \$D40 11 1 Variable Divider MSB \$00B ROM

\$F83

\$F84

SEF7

\$FF8

SEEE

FIGURE 6 - MC6805T2 MCU ADDRESS MAP

12

63

NOT USED

(52 bytes)

User RAM

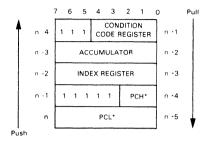
(64 bytes)

Stack

(31 bytes maximum)

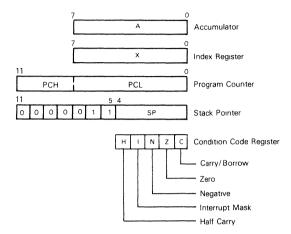
^{*}Caution Data Direction Register (DDRs) are write-only, they read as \$FF

FIGURE 7 - INTERRUPT STACKING ORDER



^{*} For subroutine calls only PCH and PCL are stacked

FIGURE 8 — PROGRAMMING MODEL



INDEX REGISTER (X) — The index register is an 8-bit register used for the indexed addressing mode. It contains an 8-bit value that may be added to an instruction value to create an effective address. The index register can also be used for data manipulations using the read/modify/write instructions. The index register may also be used as a temporary storage area.

PROGRAM COUNTER (PC) — The program counter is a 12-bit register that contains the address of the NEXT instruction to be executed

STACK POINTER (SP) — The stack point is a 12-bit register that contains the address of the next free location on the stack initially, the stack pointer is set to location \$07F and is decremented as data is being pushed onto the stack and incremented as data is being pulled from the stack. The seven most-significant bits of the stack pointer are permanently set to 0000011. During a MCU reset or the Reset Stack Pointer (RSP) instruction, the stack pointer is set to location \$07F. Subroutines and interrupts may be nested down to location \$061 (31 bytes maximum) which allows the programmer to use up to 15 levels of subroutine calls.

CONDITION CODE REGISTER (CC) — The condition code register is a 5-bit register in which four bits are used to indicate the results of the instruction just executed. These bits can be individually tested by a program and specific action taken as a result of their state Each individual condition code register bit is explained in the following paragraphs

Half Carry (H) - Set during ADD and ADC instructions to indicate that a carry occurred between bits 3 and 4

Interrupt (I) — This bit is set to mask (disable) the timer and external interrupt ($\overline{\text{INT}}$). If an interrupt occurs while this

bit is set, the interrupt is latched and is processed as soon as the interrupt bit is reset

Negative (N) — Used to indicate that the result of the LAST arithmetic, logical, or data manipulation was negative (bit 7 in result equal to a logical one)

Zero (Z) — Used to indicate that the result of the LAST arithmetic, logical, or data manipulation was zero

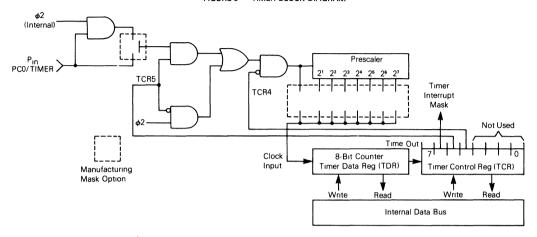
Carry/Borrow (C) — Used to indicate that a carry or borrow out of the arithmetic logic unit (ALU) occurred during the LAST arithmetic operation. This bit is also affected during bit test and branch instructions plus shifts and rotates

TIMER

The MCU timer circuitry is shown in Figure 9. The 8-bit counter may be loaded under program control and is decremented toward zero by the clock input (prescaler output). When the timer reaches zero the timer interrupt request bit (bit 7) in the Timer Control Register (TCR) is set. The timer interrupt can be masked (disabled) by setting the timer interrupt mask bit (bit 6) in the TCR. The interrupt bit (I-bit) in the Condition Code Register also prevents a timer interrupt from being processed. The MCU responds to this interrupt by saving the present CPU state in the stack, fetching the timer interrupt vector from locations \$FF8 and \$FF9 and executing the interrupt routine, see INTERRUPT section.

The timer clock input is established via bit 5 (TCR5) in the Timer Control Register. When this bit is set high, logical one (external mode), the timer clock source is the PCO/TIMER pin. In this mode a mask option is used to select either. a) the gated $\phi 2$ with PCO or b) the positive transition on PCO/TIMER as timer clock source. This allows easily performed pulse width or pulse count measurements. When TCR5 is low, logical zero, the timer clock source is the internal $\phi 2$.

FIGURE 9 - TIMER BLOCK DIAGRAM



Bit 4 in the Timer Control Register (TCR4) disables the timer clock source when set to logical one

The timer continues to count past zero, falling through to \$FF from zero, and then continuing to count. Thus, the counter can be read at any time by reading the Timer Data Register (TDR). This allows a program to determine the length of time since a timer interrupt has occurred, and not disturb the counting process.

At Powerup or Reset, the prescaler and counter are initialized with all logical ones; the timer interrupt request bit (bit 7) is cleared; the timer interrupt mask bit (bit 6) is set; the external timer source bit (bit 5) is cleared and the timer disable bit (bit 4) is cleared

SELF-CHECK

The self-check capability of the MCU provides an internal check to determine if the port is functional. Connect the MCU as shown in Figure 10 and monitor the output of Port C bit 3 for an oscillation of approximately 7 Hz A 9-volt level on the ϕ COMP input, pin 7, energizes the ROM-based self-check feature. The self-check program exercises the RAM, ROM, timer, interrupts, and I/O ports.

RESETS

The MCU can be reset two ways: by the external reset input (\overline{RESET}) and during power up time. See Figure 11

The internal circuit connected to the RESET pin consists of a Schmitt trigger which senses the RESET line logic level. The Schmitt trigger provides an internal reset voltage if it senses a logical 0 on the RESET pin. During power up, the Schmitt trigger switches on (removes reset) when the RESET pin voltage rises to VIRES+. When the RESET pin voltage rises to VIRES+. When the RESET pin voltage falls to a logical 0 for a period longer than one toyothe Schmitt trigger switches off to provide an internal reset voltage. The "switch off" voltage occurs at VIRES-. A typical reset Schmitt trigger hysteresis curve is shown in Figure 12.

Upon power up, a delay of tRHL is needed before allowing the reset input to go high. This time allows the internal clock generator to stabilize. Connecting a capacitor to the RESET

input, as shown in Figure 12, will provide sufficient delay. See Figure 17 for the complete reset sequence.

INTERNAL OSCILLATOR

The internal oscillator circuit has been designed to require a minimum of external components. The use of a crystal or an external signal may be used to drive the internal oscillator. The different connection methods are shown in Figures 13 and 14. The crystal specifications are given in Figure 15.

The crystal oscillator startup time is a function of many variables crystal parameters (especially $R_{\rm S}$), oscillator load capacitances, IC parameters, ambient temperature, and supply voltage. To ensure rapid oscillator startup, neither the crystal characteristics nor the load capacitance should exceed recommendations.

INTERRUPTS

The MCU can be interrupted three different ways through the external interrupt (\overline{INT}) input pin, the internal timer interrupt request, or the software interrupt instruction (SWI). When any interrupt occurs, processing is suspended, the present CPU state is pushed onto the stack, the interrupt bit (I) in the Condition Code Register is set, the address of the interrupt routine is obtained from the appropriate interrupt vector address, and the interrupt routine is executed. Stacking the CPU registers, setting the I-bit, and vector fetching requires a total of 11 $t_{\rm CVC}$ periods for completion

A flowchart of the interrupt sequence is shown in Figure 16. The interrupt service routine must end with a return from interrupt (RTI) instruction which allows the MCU to resume processing of the program prior to the interrupt (by unstacking the previous CPU state). Table 1 provides a listing of the interrupts, their priority, and the address of the vector which contains the starting address of the appropriate interrupt service routine. The interrupt priority applies to those pending when the CPU is ready to accept a new interrupt. RESET is listed in Table 1 because it is treated as an interrupt. However, it is not normally used as an interrupt When the interrupt mask bit in the Condition Code Register is set the interrupt is latched for later interrupt execution.

FIGURE 10 - SELF-CHECK CONNECTIONS 2 ĪNT PA7 26 MC6805T2 PA6 10μF 25 RESET PA5 PA4 23 EXTAL PA3 22 PA2 21 XTAL PA1 20 PA0 +9V фСОМР 19 PB7 18 NUM PB6 Vcc PB5 16 PB4 15 PC0/TIMER PB3 9 PC1 PB2 10 13 PC2 PB1 11 12 PB0 fın V_{CC}= Pin 3 V_{SS}= Pin 1

FIGURE 11 - POWER AND RESET TIMING

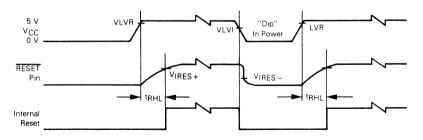


FIGURE 12 - POWERUP RESET DELAY CIRCUIT

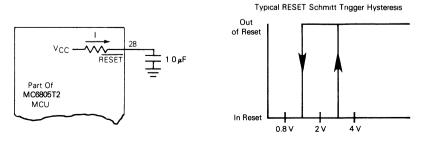
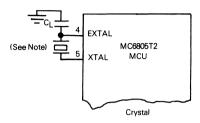


FIGURE 13 - CRYSTAL OSCILLATOR



NOTE. The recommended C_L value with a 4 0 MHz crystal is 27 pF, maximum, including system distributed capacitance. There is an internal capacitance of approximately 25 pF on the XTAL pin. For crystal frequencies other than 4 MHz, the total capacitance on each pin should be scaled as the inverse of the frequency ratio. For example, with a 2 MHz crystal, use approximately 50 pF on EXTAL and approximately 25 pF on XTAL. The exact value depends on the Motional-Arm parameters of the crystal used

FIGURE 14 - EXTERNAL OSCILLATOR

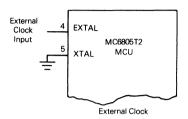
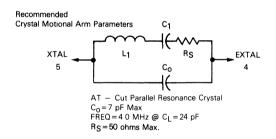
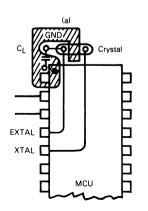
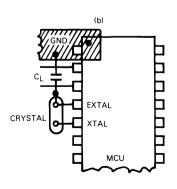


FIGURE 15 — CRYSTAL MOTIONAL ARM PARAMETERS AND SUGGESTED PC BOARD LAYOUT







Note Keep crystal leads and circuit connections as short as possible

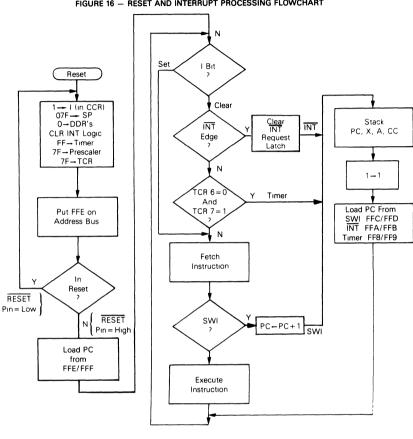


FIGURE 16 - RESET AND INTERRUPT PROCESSING FLOWCHART

TABLE 1 - INTERRUPT PRIORITIES

| Interrupt | Priority | Vector Address |
|-----------|----------|-----------------|
| RESET | 1 | \$FFE and \$FFF |
| SWI | 2* | \$FFC and \$FFD |
| ĪNT | 3 | \$FFA and \$FFB |
| Timer | 4 | \$FF8 and \$FF9 |

^{*}Priority 2 applies when the I-bit in the Condition Code Register is set When I = 0, SWI has a priority of 4, like any other instruction, the priority of INT thus becomes 2 and the timer becomes 3

The external interrupt is internally synchronized and then latched on the falling edge of INT. A sinusoidal input signal (fINT maximum) can be used to generate an external interrupt, as shown in Figure 17, for use as a Zero-Crossing Detector. For digital applications the INT can be driven by a digital signal at a maximum period of tiwi

INPUT/OUTPUT

There are 19 input/output pins (The INT pin may also be polled with branch instructions to provide an additional input pin.) All pins (Ports A, B, and C) are programmable as either inputs or outputs under software control of the corresponding Data Direction Registers (DDR). The port I/O programming is accomplished by writing the corresponding bit in the port DDR to a logic "1" for output or a logic "0" for input. On Reset all DDRs are initialized to a logic "0" state to put the ports in the input mode. The port output registers are not initialized on Reset but may be written to before setting the DDR bits to avoid undefined levels. When programmed as outputs, the latched output data is readable as input data, regardless of the logic levels at the output pin due to output loading; see Figure 18. When Port B is programmed for outputs, it is capable of sinking 10 mA and sourcing 1 mA on each pin.

FIGURE 17 - TYPICAL INTERRUPT CIRCUITS

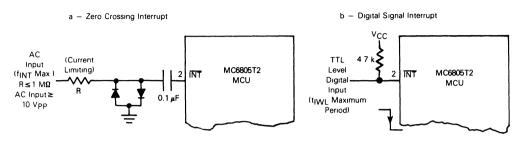
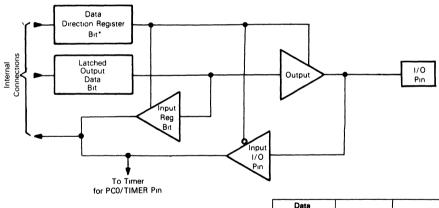


FIGURE 18 - TYPICAL PORT I/O CIRCUITRY



| Data Direction Register Bit | Output Data Bit | Output State | Input To MCU |
|--------------------------------------|-----------------------|-----------------|--------------------|
| 1 | 0 | 0 | 0 |
| 1 | 1 | 1 | 1 |
| 0 | × | 3-State** | Pin |

^{*}DDR is a write-only register and reads as all 1's

^{**}Ports A (with CMOS drive disabled), B, and C are three-state ports. Port A has optional internal pullup devices to provide CMOS drive capability. See Electrical Characteristics tables for complete information.

All input/output lines are TTL compatible as both inputs and outputs Ports B and C are CMOS compatible as inputs Port A may be made CMOS compatible as outputs with a mask option Figure 19 provides some examples of port connections The address map in Figure 6 gives the address of the data registers and DDRs. The register configuration is shown in Table 2

Caution

The corresponding DDRs for ports A, B, and C are writeonly registers (registers at \$004, \$005, and \$006) A read operation on these registers is undefined. Since BSET and BCLR are read/modify/write functions, they cannot be used to set or clear a DDR bit (all "unaffected" bits would be set) It is recommended that all DDR bits in a port be written using a single-store instruction

The latched output data bit (see Figure 18) may always be written Therefore, any write to a port writes all of its data bits even though the port DDR is set to input. This may be

used to initialize the data registers and avoid undefined outputs, however, care must be exercised when using read/ modify/write instructions since the data read corresponds to the pin level if the DDR is an input (0) and corresponds to the latched output data when the DDR is an output (1)

PHASE LOCK LOOP (PLL)

The PLL section consists of a 14-bit binary variable divider, a fixed 10-stage divider, a digital phase and frequency comparator with a three-state output, and circuitry to avoid "backlash" effects in phase lock conditions

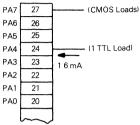
With a suitable high-frequency prescaler and an active integrator the user can easily establish a frequency synthesizer system driving a voltage controlled oscillator, as shown in Figure 20 The equations governing the PLL are given in Figure 21

TABLE 2 - MCU REGISTER CONFIGURATION

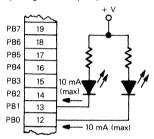
PORT DATA DIRECTION REGISTER (DDR) (1) Write Only, reads as all 1's (2) 1 = Output, 0 = Input Cleared to 0 by Reset (3) Port A Addr = \$004 Port B Addr = \$005 Port C Addr = \$006 PORT DATA REGISTER n Port A Addr = \$000 Port B Addr = \$001 Port C Addr = \$002 TIMER CONTROL REGISTER (TCR) \$000 7 5 3 2 Λ TCR7-Timer Interrupt Request Status Bit Set when TDR goes to zero, must be cleared by software Cleared to 0 by Reset TCR6-Timer Interrupt Mask Bit 1=timer interrupt masked (disabled) Set to 1 by Reset TCR5-External Timer Source 1=External, 0=Internal Cleared to 0 by Reset TCR4 - Disable Timer 1 = Timer Source Disconnected, 0 = Timer Input Enabled Cleared to 0 by Reset TCR Bits 3, 2, 1, and 0 read as 1's (not used) TIMER DATA REGISTER (TDR) \$008 Λ MSB LSB

FIGURE 19 - TYPICAL PORT CONNECTIONS

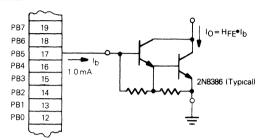
a. Output Modes



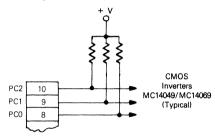
Port A, Bit 7 Programmed as Output, Driving CMOS Loads and Bit 4 Driving one TTL Load Directly (using CMOS output option)



Port B, Bit 0 and Bit 1 Programmed as Output, Driving LEDs Directly

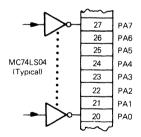


Port B, Bit 5 Programmed as Output, Driving Darlington-Base Directly.

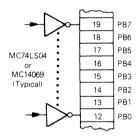


Port C, Bits 0-3 Programmed as Output, Driving CMOS Loads, Using External Pullup Resistors

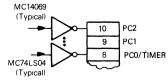
b. Input Modes



TTL Driving Port A Directly



CMOS or TTL Driving Port B Directly



CMOS and TTL Driving Port C Directly

VARIABLE DIVIDER

The variable divider is a 14-bit binary down counter which communicates with the CPU via two read/write registers located at address \$00A, for the LS byte, and \$00B, for the MS byte The upper two bits in register \$00B, always read as logical "1's" When the variable divider count has reached zero a preset pulse, f_{VAR} , is generated. This is used to reload the variable divider with the contents of the 14-bit latch as shown in Figure 22

Data transfers from registers \$00A and \$00B to the latch occur outside the preset time and only during a write operation performed on register \$00A. For example, a 6-bit data transfer to register \$00B is only transferred to the variable divider if followed by a write operation to register \$00A. Figure 23 shows a typical error free manipulation of the 14-bit data in the fine tuning operations.

The use of the 14-bit latch synchronizes the data transfer between two asynchronous systems, namely, the CPU and the variable divider

At power up reset both the variable divider and the contents of the PLL registers are set to logical "1's"

The variable frequency input pin, f_{in} , is self biased requiring an ac coupled signal with a normal swing of 0.5 V. The input frequency range of f_{in} allows the device, together with a suitable prescaler, to cover the entire TV frequency spectrum.

REFERENCE DIVIDER

This 10-stage binary counter generates a reference frequency, f_{REF}, which is compared with the output of the variable divider. The reference divider is mask programmable, thus, allowing the user a choice of reference frequency, see Figure 22.

FIGURE 20 - PHASE LOCK LOOP AN AN RF FREQUENCY SYNTHESIZER

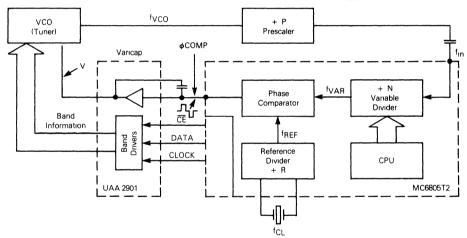


FIGURE 21 - PRINCIPAL PLL EQUATIONS

```
For a system in lock.
       fVAR = fREF
since<sub>1</sub> f<sub>in</sub>
                 = f<sub>in</sub> • N
        fvco = fREF • P
where P = prescaler division ration
       fvco = free P N
Minimum frequency step =
       \Delta f_{VCO} = f_{REF} \cdot P
         \Delta N
e.g. fCL
                 = 4 00 MHz
                 = 210
where R
                 = the reference divider ratio
                 = 64
       \Delta f_{VCO} = 62.5 \text{ kHz}
                = 976 5 Hz
       fREF
```

FIGURE 22 - MC6805T2 PLL BLOCK DIAGRAM

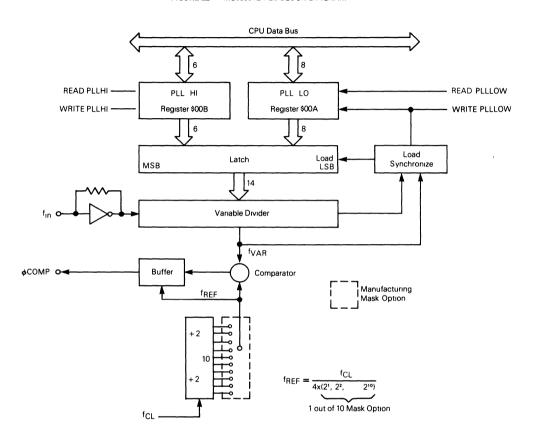


FIGURE 23 - TYPICAL FINE TUNE EXAMPLE

| FTUP | LDA INCA BNE INC INC | PLLLOW TT1 PLLLOW PLLLOW | check if LS byte=\$FF (Reg \$00A) if not increment only LS byte increment MSB (Reg \$00B) before LSB |
|-------|----------------------------------|-----------------------------------|--|
| FTDWN | TST BNE DEC DEC | PLLLOW TT2 PLLHI PLLLOW | check if LS byte=\$00 if not decrement only LS byte decrement MSB before LSB |
| | • | | |

PHASE COMPARATOR

The phase comparator compares the frequency and phase of f_{VAR} and f_{REF} , and according to their phase relationship generates a three-level output, $\phi COMP$, as shown in Figures 24 and 25. The output waveform is then integrated, amplified, and the resultant dc voltage is applied to the voltage controlled oscillator

In practice a linear characteristic around the steady-state region can not be achieved due to internal propagation

delays. Thus, phase comparators exhibit non-linear characteristics and for systems which lock in phase, this results in a 'backlash' effect — creating sidebands and FM distortion. To avoid this effect a very short pulse is injected periodically into the system. The loop, in turn, attempts to cancel this interference. and in doing so brings the phase comparator to its linear zone, as shown in Figures 26 and 27.

A typical application, for a TV frequency synthesizer, is illustrated in Figure 28

FIGURE 24 - PHASE COMPARATOR STATE DIAGRAM

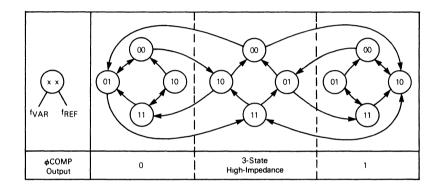


FIGURE 25 - PHASE COMPARATOR OUTPUT WAVEFORM

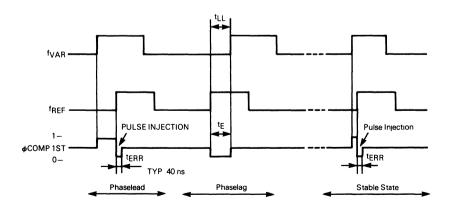


FIGURE 26 - PHASE COMPARATOR CHARACTERISTICS

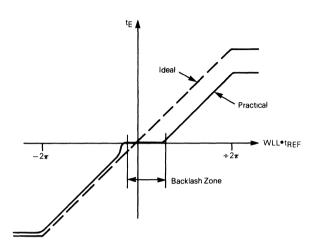
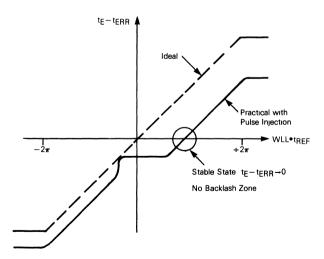


FIGURE 27 — PHASE COMPARATOR WITH PULSE INJECTION



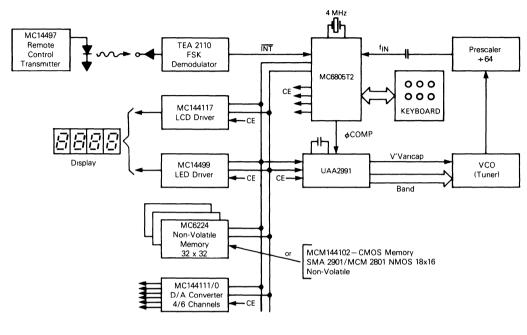


FIGURE 28 - A TYPICAL TV SYNTHESIZER APPLICATION

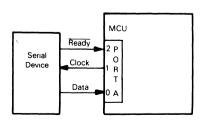
BIT MANIPULATION

The MCU has the ability to set or clear any single random-access memory or input/output bit (except the Data Direction Registers, see Caution under INPUT/OUTPUT paragraph), with a single instruction (BSET, BCLR) Any bit in page zero including ROM, except the DDRs, can be tested, using the BRSET and BRCLR instructions, and the program branches as a result of its state. The Carry bit equals the value of the bit referenced by BRSET and BRCLR. A Rotate instruction may then be used to accumulate serial input data in a RAM location or register. The capability to work with any bit in RAM, ROM, or I/O allows the user to

have individual flags in RAM or to handle I/O bits as control lines $\,$

The coding example in Figure 29 illustrates the usefulness of the bit manipulation and test instructions. Assume that the MCU is to communicate with an external serial device. The external device has a data ready signal, a data output line, and a clock line to clock data one bit at a time, LSB first, out of the device. The MCU waits until the data is ready, clocks the external device, picks up the data in the Carry Flag (C-bit), clears the clock line and finally accumulates the data bits in a RAM location.

FIGURE 29 - BIT MANIPULATION EXAMPLE



ADDRESSING MODES

The MCU has 10 addressing modes which are explained briefly in the following paragraphs. For additional details and graphical illustrations, refer to the M6805 Family Users Manual.

The term "effective address" (EA) is used in describing the address modes EA is defined as the address from which the argument for an instruction is fectched or stored

IMMEDIATE — In the immediate addressing mode, the operand is contained in the byte immediately following the opcode. The immediate addressing mode is used to access constants which do not change during program execution (e.g., a constant used to initialize a loop counter).

DIRECT — In the direct addressing mode, the effective address of the argument is contained in a single byte following the opcode byte Direct addressing allows the user to directly address the lowest 256 bytes in memory with a single 2-byte instruction. This includes the on-chip RAM and I/O registers and 128 bytes of ROM. Direct addressing is an effective use of both memory and time.

EXTENDED — In the extended addressing mode, the effective address of the argument is contained in the two bytes following the opcode Instructions using extended addressing are capable of referencing arguments anywhere in memory with a single 3-byte instruction. When using the Motorola assembler, the programmer need not specify whether an instruction uses direct or extended addressing. The assembler automatically selects the shortest form of the instruction.

RELATIVE — The relative addressing mode is only used in branch instructions. In relative addressing, the contents of the 8-bit signed byte following the opcode (the offset) is added to the PC if and only if the branch condition is true. Otherwise, control proceeds to the next instruction. The span of relative addressing is from —126 to +129 from the opcode address. The programmer need not worry about calculating the correct offset when using the Motorola assembler, since it calculates the proper offset and checks to see if it is within the span of the branch.

INDEXED, NO OFFSET — In the indexed, no offset addressing mode, the effective address of the argument is contained in the 8-bit index register. Thus, this addressing mode can access the first 256 memory locations. These instructions are only one byte long. This mode is often used to move a pointer through a table or to hold the address of a frequently referenced RAM or I/O location.

INDEXED, 8-BIT OFFSET — In the indexed, 8-bit offset addressing mode the effective address is the sum of the contents of the unsigned 8-bit index register (X) and the unsigned byte following the opcode. This addressing mode is useful in selecting the kth element in an n element table. With this 2-byte instruction, k would typically be in X with the address of the beginning of the table in the instruction. As such tables may begin anywhere within the first 256 addressable locations and could extend as far as location 511 (\$1FE).

INDEXED, 16-BIT OFFSET — In the indexed, 16-bit offset addressing mode, the effective address is the sum of the contents of the unsigned 8-bit index register and the two unsigned bytes following the opcode. This addressing mode can be used in a manner similar to indexed, 8-bit offset, except that this 3-byte instruction allows tables to be anywhere in memory.

BIT SET/CLEAR — In the bit set/clear addressing mode, the bit to be set or cleared is part of the opcode, and the byte following the opcode specifies the page-zero address of the byte in which the specified bit is to be set or cleared. Thus, any read/write bit in the first 256 locations of memory, including I/O, can be selectively set or cleared with a single 2-byte instruction. See Caution under the INPUT/OUTPUT paragraph.

BIT TEST AND BRANCH — The bit test and branch addressing mode is a combination of direct addressing and relative addressing. The bit and condition (set or clear) is included in the opcode, which is to be tested and the address of the byte to be tested is in the single byte immediately following the opcode byte. The signed relative 8-bit offset in the third byte is added to the value of the PC if the branch condition is true. This single 3-byte instruction allows the program to branch based on the condition of any readable bit in the first 256 locations of memory. The span of branching is from +130 to -125 from the opcode address. The state of the tested bit is also transferred to the Carry bit of the Condition Code Register. See Caution under the IN-PUT/OUTPUT paragraph.

INHERENT — In the inherent addressing mode, all the information necessary to execute the instruction is contained in the opcode. Operations specifying only the index register or accumulator, as well as control instruction with no other arguments, are included in this mode. These instructions are one byte long.

INSTRUCTION SET

The MCU has a set of 59 basic instructions, which when combined with the 10 addressing modes produce 207 usable opcodes. They can be divided into five different types register/memory, read/modify/write, branch, bit manipulation, and control. The following paragraphs briefly explain each type. All the instructions within a given type are presented in individual tables.

REGISTER/MEMORY INSTRUCTIONS — Most of these instructions use two operands. One operand is either the accumulator or the index register. The other operand is obtained from memory using one of the addressing modes. The jump unconditional (JMP) and jump to subroutine (JSR) instructions have no register operand. Refer to Table 3.

READ/MODIFY/WRITE INSTRUCTIONS — These instructions read a memory location or a register, modify or test its contents, and write the modified value back to memory or to the register (see Cautions under INPUT/OUT-PUT paragraph). The test for negative or zero (TST) instruction is included in the read/modify/write instructions though it does not perform the write. Refer to Table 4.

TABLE 3 — REGISTER/MEMORY INSTRUCTIONS

| | | | | | | | | | А | ddressin | g Mode | es | | | | | | | |
|---|----------|------------|------------|-------------|------------|------------|-------------|------------|------------|-------------|------------|-----------------|-------------|------------|------------|-------------|------------|------------------|-------------|
| | | | Immed | ıate | | Direc | et | | Extend | ed | (| Index No Off | | (8 | Index | | (10 | Index 6-Bit C | |
| Function | Mnemonic | Op Code | # Bytes | # Cycles | Op Code | # Bytes | # Cycles | Op Code | # Bytes | # Cycles | Op Code | # Bytes | # Cycles | Op Code | # Bytes | # Cycles | OP Code | # Bytes | # Cycles |
| Load A from Memory | LDA | A6 | 2 | 2 | В6 | 2 | 4 | C6 | 3 | 5 | F6 | 1 | 4 | E6 | 2 | 5 | D6 | 3 | 6 |
| Load X from Memory | LDX | AE | 2 | 2 | BE | 2 | 4 | CE | 3 | 5 | FE | 1 | 4 | EE | 2 | 5 | DE | 3 | 6 |
| Store A in Memory | STA | _ | - | - | B7 | 2 | 5 | C7 | 3 | 6 | F7 | 1 | 5 | E7 | 2 | 6 | D7 | 3 | 7 |
| Store X in Memory | STX | _ | | _ | BF | 2 | 5 | CF | 3 | 6 | FF | 1 | 5 | EF | 2 | 6 | DF | 3 | 7 |
| Add Memory to A | ADD | AB | 2 | 2 | BB | 2 | 4 | СВ | 3 | 5 | FB | 1 | 4 | EB | 2 | 5 | DB | 3 | 6 |
| Add Memory and Carry to A | ADC | А9 | 2 | 2 | В9 | 2 | 4 | C9 | 3 | 5 | F9 | 1 | 4 | E9 | 2 | 5 | D9 | 3 | 6 |
| Subtract Memory | SUB | A0 | 2 | 2 | во | 2 | 4 | СО | 3 | 5 | FO | 1 | 4 | EO | 2 | 5 | D0 | 3 | 6 |
| Subtract Memory from A with Borrow | SBC | A2 | 2 | 2 | B2 | 2 | 4 | C2 | 3 | 5 | F2 | 1 | 4 | E2 | 2 | 5 | D2 | 3 | 6 |
| AND Memory to A | AND | Α4 | 2 | 2 | В4 | 2 | 4 | C4 | 3 | 5 | F4 | 1 | 4 | E4 | 2 | 5 | D4 | 3 | 6 |
| OR Memory with A | ORA | AA | 2 | 2 | BA | 2 | 4 | CA | 3 | 5 | FA | 1 | 4 | EA | 2 | 5 | DA | 3 | 6 |
| Exclusive OR Memory with A | EOR | A8 | 2 | 2 | 88 | 2 | 4 | С8 | 3 | 5 | F8 | 1 | 4 | E8 | 2 | 5 | D8 | 3 | 6 |
| Arithmetic Compare A with Memory | СМР | Α1 | 2 | 2 | В1 | 2 | 4 | C1 | 3 | 5 | F1 | 1 | 4 | E1 | 2 | 5 | D1 | 3 | 6 |
| Arithmetic Compare X with Memory | СРХ | А3 | 2 | 2 | В3 | 2 | 4 | С3 | 3 | 5 | F3 | 1 | 4 | E3 | 2 | 5 | D3 | 3 | 6 |
| Bit Test Memory with A (Logical Compare) | ВІТ | A 5 | 2 | 2 | В5 | 2 | 4 | C5 | 3 | 5 | F5 | 1 | 4 | E5 | 2 | 5 | D5 | 3 | 6 |
| Jump Unconditional | JMP | - | - | _ | BC | 2 | 3 | CC | 3 | 4 | FC | 1 | 3 | EC | 2 | 4 | DC | 3 | 5 |
| Jump to Subroutine | JSR | _ | - | - | BD | 2 | 7 | CD | 3 | 8 | FD | 1 | 7 | ED | 2 | 8 | DD | 3 | 9 |

TABLE 4 - READ/MODIFY/WRITE/ INSTRUCTIONS

| | | | | | | | | Addr | essing | Modes | | | | | | |
|------------------------------|----------|------------|------------|-------------|------------|------------|-------------|------------|------------|-------------|------------|------------|-------------|------------|----------------|-------------|
| | | 10 | nheren | t (A) | - | nheren | t (X) | | Direc | ct | (| Index | | (8 | Index Bit O | |
| Function | Mnemonic | Op Code | # Bytes | # Cycles | Op Code | # Bytes | # Cycles | Op Code | # Bytes | # Cycles | Op Code | # Bytes | # Cycles | Op Code | # Bytes | # Cycles |
| Increment | INC | 4C | 1 | 4 | 5C | 1 | 4 | 3C | 2 | 6 | 7C | 1 | 6 | 6C | 2 | 7 |
| Decrement | DEC | 4A | 1 | 4 | 5A | 1 | 4 | 3A | 2 | 6 | 7A | 1 | 6 | 6A | 2 | 7 |
| Clear | CLR | 4F | 1 | 4 | 5F | 1 | 4 | 3F | 2 | 6 | 7F | 1 | 6 | 6F | 2 | 7 |
| Complement | сом | 43 | 1 | 4 | 53 | 1 | 4 | 33 | 2 | 6 | 73 | 1 | 6 | 63 | 2 | 7 |
| Negate (2's Complement) | NEG | 40 | 1 | 4 | 50 | 1 | 4 | 30 | 2 | 6 | 70 | 1 | 6 | 60 | 2 | 7 |
| Rotate Left Thru Carry | ROL | 49 | 1 | 4 | 59 | 1 | 4 | 39 | 2 | 6 | 79 | 1 | 6 | 69 | 2 | 7 |
| Rotate Right Thru Carry | ROR | 46 | 1 | 4 | 56 | 1 | 4 | 36 | 2 | 6 | 76 | 1 | 6 | 66 | 2 | 7 |
| Logical Shift Left | LSL | 48 | 1 | 4 | 58 | 1 | 4 | 38 | 2 | 6 | 78 | 1 | 6 | 68 | 2 | 7 |
| Logical Shift Right | LSR | 44 | 1 | 4 | 54 | 1 | 4 | 34 | 2 | 6 | 74 | 1 | 6 | 64 | 2 | 7 |
| Arithmetic Shift Right | ASR | 47 | 1 | 4 | 57 | 1 | 4 | 37 | 2 | 6 | 77 | 1 | 6 | 67 | 2 | 7 |
| Test for Negative or Zero | TST | 4D | 1 | 4 | 5D | 1 | 4 | 3D | 2 | 6 | 7D | 1 | 6 | 6D | 2 | 7 |

BRANCH INSTRUCTIONS — The branch instructions cause a branch from the program when a certain condition is met. Refer to Table 5.

BIT MANIPULATION INSTRUCTIONS — These instructions are used on any bit in the first 256 bytes of the memory (see Cautions under INPUT/OUTPUT paragraph). One group either sets or clears. The other group performs the bit test branch operations Refer to Table 6.

CONTROL INSTRUCTIONS — The control instructions control the MCU operations during program execution Refer to Table 7.

 $\begin{tabular}{ll} ALPHABETICAL LISTING - The complete instruction set is given in alphabetical order in Table 8 \end{tabular}$

OPCODE MAP SUMMARY — Table 9 is an opcode map for the instructions used on the MCU.

TABLE 5 - BRANCH INSTRUCTIONS

| | | Relative | Addressi | ng Mode |
|--|----------|----------|----------|---------|
| | | Op | # | # |
| Function | Mnemonic | Code | Bytes | Cycles |
| Branch Always | BRA | 20 | 2 | 4 |
| Branch Never | BRN | 21 | 2 | 4 |
| Branch IFF Higher | вні | 22 | 2 | 4 |
| Branch IFF Lower or Same | BLS | 23 | 2 | 4 |
| Branch IFF Carry Clear | BCC | 24 | 2 | 4 |
| (BranchlFFHigher or Same) | (BHS) | 24 | 2 | 4 |
| Branch IFF Carry Set | BCS | 25 | 2 | 4 |
| (Branch IFF Lower) | (BLO) | 25 | 2 | 4 |
| Branch IFF Not Equal | BNE | 26 | 2 | 4 |
| Branch IFF Equal | BEQ | 27 | 2 | 4 |
| Branch IFF Half Carry Clear | внсс | 28 | 2 | 4 |
| Branch IFF Half Carry Set | BHCS | 29 | 2 | 4 |
| BranchIFF Plus | BPL | 2A | 2 | 4 |
| BranchIFF Minus | BMI | 2B | 2 | 4 |
| Branch IFF Interupt Mask Bit is Clear | вмс | 2C | 2 | 4 |
| BranchiFFInterrupt Mask Bit is Set | BMS | 2D | 2 | 4 |
| BranchIFFInterrupt Line is Low | BIL | 2E | 2 | 4 |
| Branch IFF Interrupt Line is High | він | 2F | 2 | 4 |
| Branch to Subroutine | BSR | AD | 2 | 8 |

TABLE 6 - BIT MANIPULATION INSTRUCTIONS

| | | | | Addres | sing Mode | \$ | |
|---------------------------|-------------------|------------|--------|--------|------------|----------|--------|
| | | Bit | Set/Cl | ear | Bit Te | st and E | Branch |
| | | Op | # | # | Op | # | # |
| Function | Mnemonic | Code | Bytes | Cycles | Code | Bytes | Cycles |
| Branch IFF Bit n is set | BRSET n (n = 0 7) | - | | _ | 2 • n | 3 | 10 |
| Branch IFF Bit n is clear | BRCLR n (n = 0 7) | _ | _ | _ | 01 + 2 • n | 3 | 10 |
| Set Bit n | BSET n (n = 0 7) | 10 + 2 • n | 2 | 7 | _ | _ | _ |
| Clear bit n | BCLR n (n = 0 7) | 11 + 2 • n | 2 | 7 | _ | - | |

TABLE 7 - CONTROL INSTRUCTIONS

| | | | Inherent | |
|--------------------------|----------|------|----------|--------|
| | | Op | # | # |
| Function | Mnemonic | Code | Bytes | Cycles |
| Transfer A to X | TAX | 97 | 1 | 2 |
| Transfer X to A | TXA | 9F | 1 | 2 |
| Set Carry Bit | SEC | 99 | 1 | 2 |
| Clear Carry Bit | CLC | 98 | 1 | 2 |
| Set Interrupt Mask Bit | SEI | 9B | 1 | 2 |
| Clear Interrupt Mask Bit | CLI | 9A | 1 | 2 |
| Software Interrupt | SWI | 83 | 1 | 11 |
| Return from Subroutine | RTS | 81 | 1 | 6 |
| Return from Interrupt | RTI | 80 | 1 | 9 |
| Reset Stack Pointer | RSP | 9C | 1 | 2 |
| No-Operation | NOP | 9D | 1 | 2 |

TABLE 8 - INSTRUCTION SET

| | <u> </u> | | | Ac | dressing | Modes | | | | | Co | nd | itio | n C | ode |
|----------|--|---|--|--|---|--|---|--|--|--|----|----|--------|-----|----------|
| | | | | T | l . | | · · · · · · | <u> </u> | Bit | Bit | - | | 1 | Ë | OGE |
| | | | | İ | | Indexed | Indexed | Indexed | | Test & | | | | | |
| Mnemonic | Inherent | Immediate | Direct | Extended | Relative | (No Offset) | (8 Bits) | (16 Bits) | Clear | Branch | н | 1 | N | z | С |
| ADC | | X | X | , X | | X | × | × | | | ٨ | • | ٨ | ٨ | ٨ |
| ADD | | X | X | X | | × | X | X | | | ٨ | • | ٨ | ٨ | ٨ |
| AND | | X | Х | Х | | × | X | X | | | • | • | ٨ | Λ | • |
| ASL | X | | × | | | × | Х | | | | • | • | ٨ | ٨ | ٨ |
| ASR | X | | X | | | X | X | | | | • | • | Λ | Λ | ٨ |
| BCC | | | <u> </u> | | X | | | | | | • | • | • | • | • |
| BCLR | | | | | † | | | <u> </u> | × | | • | • | • | • | • |
| BCS | | | | | X | | | | | | • | • | • | • | • |
| BEQ | | | | | X | | | | | | • | • | • | • | • |
| ВНСС | | | | | X | | | | | | • | • | • | • | • |
| BHCS | - | | | | X | | | | | | • | • | • | • | • |
| ВНІ | † | † | | | X | | | - | | | • | • | • | • | • |
| BHS | 1 | 1 | | 1 | × | | | T | † | | • | • | • | • | • |
| BIH | | | | | X | | | | | | • | • | • | • | • |
| BIL | + | | | | X | | | | | | - | • | • | - | • |
| BIT | | x | x | × | + | x | x | X | | | • | • | \ \ | ^ | • |
| BLO | + | +-~- | ~ | | x | ~ | | ~ | | | • | • | • | • | • |
| BLS | + | + | | | 1 × | | | + | | | • | • | • | • | • |
| BMC | | | | | | | | | ├ | | - | • | • | • | • |
| BMI | | | | | ^ | | | | | | • | - | • | • | • |
| BMS | | + | | | | | | | | | - | • | • | • | • |
| BNE | | <u> </u> | | ļ | | } | | } | | | - | _ | - | _ | - |
| BPL | | | } | | | | | | | | - | • | • | • | • |
| BRA | | | | | ├ - | | | | | | - | • | • | • | • |
| BRN | + | | | | | ļ | ļ | | | <u> </u> | - | • | • | • | • |
| BRCLR | | | | | + | | | | ├ | X | • | • | • | • | |
| BRSET | | | | | | | | | | X | • | • | • | • | <u> </u> |
| BSET | | + | | | + | <u> </u> | | | × | ^- - | - | • | • | • | <u> </u> |
| BSR | | | | + | l x | | ļ | | ^- - | | - | • | • | • | • |
| CLL | x | | | | ^- | | | | ļ | | - | • | • | • | |
| CLI | + ^ | | | | | } | ļ | | ├ | | • | - | + | - | 0 |
| CLR | + ^ | | × | + | | × | × | | ├ | | + | 0 | • | • | |
| CMP | ^ - | × | ^ | + x | | + ^ | l ^ | × | | | • | • | 0 | 1 | • |
| | × | | x | | | \ x | × | ^ | } | | +- | - | - | ^ | <u>^</u> |
| СОМ | ^ | ↓ | ^ | × | | | X | | ├ | | • | • | ^ | ۸ | 1 |
| CPX | x | X | × | | | + x | X | X | } | | • | • | - | ^ | ^ |
| DEC | ^ _ | x - | ` | + x | | \ \ \ \ \ \ \ \ \ | I | | | | | • | 1 | ^ | • |
| EOR | + | | X | ^ | | 1 | X | X | | | • | • | ٨ | ۸ | • |
| INC | × | _ | 1 | | | X | X | | | | • | • | ^ | ^ | • |
| JMP | _ | | X | X | | X | X | X | ļ | | • | • | • | • | • |
| JSR | ↓ | | X | X | | X | X | X | <u> </u> | L | • | • | • | • | • |
| LDA | | X | X | X | | X | X | X | ↓ | | • | • | 1 | 1 | • |
| LDX | <u> </u> | X | X | × | | X | X | × | <u> </u> | | • | • | _ | ^ | • |
| LSL | X | 4 | X | | ↓ | X | X | ļ | L | | • | • | ^ | ^ | ^ |
| LSR | X | <u> </u> | X | | L | X | X | <u> </u> | | <u> </u> | • | • | 0 | 1 | ^ |
| NEQ | Х | | X | ļ | | Х | X | <u> </u> | <u> </u> | | • | • | 1 | ^ | 1^ |
| NOP | X | | | | | | | L | <u> </u> | | • | • | • | • | • |
| ORA | | Х | Х | X | | Х | × | X | | | • | • | ^ | _ | • |
| ROL | X | | X | | | Х | X | | | | • | • | - | ^ | ٨ |
| RSP | X | 1 | 1 | | | 1 | 1 | 1 | 1 | | • | • | • | • | • |

Condition Code Symbols

- H Half Carry (From Bit 3)
 I Interrupt Mask
- N Negative (Sign Bit)
 Z Zero

- C Carry/Borrow

 ∧ Test and Set if True, Cleared Otherwise
- Not Affected

TABLE 8 - INSTRUCTION SET (CONTINUED)

| | | | | A | ddressing | Modes | | | | Co | nd | itio | n C | ode |
|----------|----------|-----------|--------|----------|-----------|------------------------|---|----------------------|-------------------------|----|----|------|-----|-----|
| Mnemonic | Inherent | Immediate | Direct | Extended | Relative | Indexed (No Offset) | | Indexed (16 Bits) | Bit Test & Branch | н | | N | z | С |
| RTI | X | | | | | | | | | ? | 7 | ? | ? | ? |
| RTS | X | | | | | | | | | • | • | • | • | • |
| SBC | | X | Х | Х | | × | × | × | | • | • | ٨ | ٨ | ٨ |
| SEC | X | | | | | | | | | • | • | • | • | 1 |
| SEI | X | | | | | | | | | • | 1 | • | • | • |
| STA | | | Х | X | | X | × | × | | • | • | ٨ | ^ | • |
| STX | | | Х | X | | × | × | × | | • | • | ٨ | ٨ | • |
| SUB | | × | Х | X | | × | X | × | | • | • | ^ | ٨ | ٨ |
| SWI | Х | | | | | | | | | • | 1 | • | • | • |
| TAX | X | | | | | | | | | • | • | • | • | • |
| TST | Х | | Х | | | X | × | | | • | • | ^ | ^ | • |
| TXA | Х | | | | | | | | | • | • | • | • | • |

Condition Code Symbols

- H Half Carry (From Bit 3)
 I Interrupt Mask
- N Negative (Sign Bit)
- Z Zero

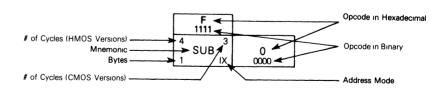
- C Carry/Borrow Λ Test and Set if True, Cleared Otherwise
- Not Affected
- Property of the Property of

TABLE 9 - M6805 FAMILY INSTRUCTION OPCODE MAP

| | Bit Mar | nipulation | Branch | | Re | ad/Modify/ | Write | | Con | itrol | F | | Registe | r/Memory | | | |
|-----------|-------------------------|-----------------------|---------------------|-----------------------|----------------------|-----------------|---------------------|---------------|-----------------------|---------------------|---------------------|---------------------|---------------------|----------------|---------------------|------------|--------------------|
| | BTB | BSC | REL | DIR | INH(A) | INH(X) | IX1 | IX | INH | INH | IMM | DIR | EXT | IX2 | IX1 | IX | <u> </u> |
| TOM H | 0000 | 0001 | 0010 | 3 0011 | 0100 | 5 0101 | 6 0110 | 0111 | 1000 | 9 1001 | 1010 | B 1011 | 1100 | D 1101 | 1110 | 1111 | H _I Low |
| 0000 | BRSETO 3 BTB | BSET0 BSC | BRA 2 REL | 6 NEG 2 DIR | NEGA 1 INH | 4 NEGX 1 INH | 7 NEG 2 IX1 | 6 NEG 5 | RTI 1 INH | | SUB 2 IMM | SUB 2 DIR | SUB 3 EXT | SUB 3 IX2 | SUB 1X1 | SUB IX | 0000 |
| 1 1 | BRCLRO 3 BTB | BCLR0 2 BSC | BRN 2 REL | | | | | | 6 RTS 1 INH | | CMP 2 IMM | 4 CMP 2 DIR | CMP 3 EXT | CMP 3 IX2 | CMP 2 IX1 | CMP | 1 0001 |
| 2 0010 | 10 5 BRSET1 3 BTB | BSET1 2 BSC | BHI 2 REL | | | | | | | | SBC 2 2 IMM | SBC 3 | SBC 3 EXT | 6 SBC 5 | SBC 2 IX1 | SBC | 2 0010 |
| 3 0011 | 10 5 BRCLR1 3 BTB | 7 BCLR1 2 BSC | BLS 2 REL | 6 COM 2 DIR | COMA 1 INH | COMX 1 INH | COM 2 IX1 | 6 COM 5 | 11 10 SWI 1 INH | | CPX 2 1MM | | 5 CPX 3 EXT | 6 CPX 5 | CPX 2 IX1 | CPX IX | 3 0011 |
| 4 0100 | 10 5 BRSET2 3 BTB | 7 5 BSET2 2 BSC | BCC REL | 6 LSR 2 DIR | 4 3 LSRA 1 INH | 4 LSRX 1 INH | 7 LSR 2 IX1 | 6 LSR 1 IX | | | 2 AND 2 IMM | | AND 3 EXT | AND 3 IX2 | AND 2 IX1 | AND IX | 4 0100 |
| 5 0101 | 10 5 BRCLR2 3 BTB | 7 BCLR2 2 BSC | BCS REL | | | | | | | | BIT 2 2 IMM | BIT DIR | BIT 3 EXT | BIT 3 IX2 | BIT 2 IX1 | BIT IX | 5 0101 |
| 6 0110 | BRSET3 3 BTB | BSET3 | BNE REL | 6 ROR 2 DIR | RORA 1 INH | RORX 1 INH | ROR 2 IX1 | ROR IX | | | LDA LDA 2 IMM | | LDA 3 EXT | 6 LDA 5 | 5 LDA 2 IX1 | LDA IX | 6 0110 |
| 7 0111 | BRCLR3 3 BTB | BCLR3 2 BSC | BEQ 2 REL | 6 ASR 2 DIR | 4 ASRA 1 INH | ASRX 1 INH | 7 ASR 2 IX1 | 6 ASR 5 | | 2 Z TAX 1 INH | | | STA 3 EXT | 7 STA 6 | 6 STA 2 1X1 | STA IX | 7 0111 |
| 8 | BRSET4 3 BTB | BSET4 BSC | BHCC REL | 6 - 5 LSL 2 DIR | 4 3 LSLA 1 INH | LSLX 1 INH | 7 LSL 2 IX1 | 6 LSL 1 IX | | 2 2 CLC 1 INH | EOR 2 | EOR 2 DIR | EOR 3 EXT | 6 EOR 5 | 5 EOR 2 IX1 | EOR IX | 8 1000 |
| 9 1001 | BRCLR4 3 BTB | 7 BCLR4 2 BSC | BHCS 2 REL | 6 FOL 2 DIR | 4 ROLA 1 INH | ROLX 1 INH | 7 6 ROL 2 IX1 | 6 ROL 1 IX | | SEC 2 1 INH | ADC 2 2 IMM | ADC 2 DIR | ADC 3 EXT | ADC IX2 | ADC 2 IX1 | ADC IX | 9 1001 |
| A 1010 | 10 5 BRSET5 3 BTB | BSET5 2 BSC | BPL 2 REL | 6 DEC 2 DIR | DECA 1 INH | DECX 1 INH | 7 DEC 2 IX1 | 6 DEC 1 | | CLI INH | ORA 2 IMM | | ORA 3 EXT | ORA 3 IX2 | 5 ORA 2 IX1 | ORA | A 1010 |
| B 1011 | 10 5 BRCLR5 3 BTB | 7 BCLR5 2 BSC | BMI 2 REL | | | | | | | SEI | ADD 2 | ADD | 5 ADD 3 EXT | 6 ADD 5 | 5 ADD 1X1 | 4 ADD 3 | B 1011 |
| C 110 | BRSET6 3 BTB | BSET6 2 BSC | BMC 2 REL | 6 INC 2 DIR | INCA 1 INH | INCX 1 INH | INC 2 X1 | 6 INC 5 | | RSP INH | | JMP 2 DIR | 4 3 JMP 3 EXT | 5 JMP 3 IX2 | 4 3 JMP 2 IX1 | 3 2 JMP | C 1100 |
| D 1101 | BRCLR6 3 BTB | 7 BCLR6 2 BSC | BMS 2 REL | 6 4 TST 2 DIR | 4 3 TSTA 1 INH | TSTX | 7 TST 2 IX1 | 6 TST IX | | NOP INH | B BSR 2 REL | 7 5 JSR 2 DIR | 8 6 JSR 3 EXT | JSR | 8 6 JSR 2 IX1 | JSR IX | D 1101 |
| E 1110 | 10 5 BRSET7 3 BTB | 7 BSET7 2 BSC | BIL 2 REL | | | | | | STOP 2 | | 2 LDX 2 IMM | 4 LDX 2 DIR | 5 LDX 3 EX. | 6 LDX 3 IX2 | 5 LDX 2 IX1 | 4 LDX 1 | E 1110 |
| F 1111 | BRCLR7 3 BTB | BCLR7 BSC | 4 3 BIH 2 REL | 6 CLR 2 DIR | 4 CLRA 1 INH | 4 CLRX 1 INH | 7 CLR 2 IX1 | 6 CLR 1 | WAIT 1 INH | 2 Z TXA 1 INH | | 5 STX 2 DIR | 6 STX 3 EXT | 7 STX 3 IX2 | 6 STX 2 IX1 | 5 STX 1 | F 1111 |

Abbreviations for Address Modes

INH Inherent IMM Immediate DIR Direct EXT Extended REL Relative BSC Bit Set/Clear BTB Bit Test and Branch IX Indexed (No Offset) IX1 Indexed, 1 Byte (8-Bit) Offset IX2 Indexed, 2 Byte (16-Bit) Offset CMOS Versions Only



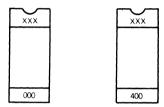
LEGEND

ORDERING INFORMATION

The information required when ordering a custom MCU is listed below. The ROM program may be transmitted to Motorola on EPROM(s) or on MDOS disk file.

To initiate a ROM pattern for the MCU it is necessary to first contact your local Motorola representative or distributor

EPROMs – The MCM2716 or MCM2532 type EPROMs, programmed with the customer program (positive logic sense for address and data), may be submitted for pattern generation. The EPROM must be clearly marked to indicate which EPROM corresponds to which address space. The recommended marking procedure is illustrated below.



XXX = Customer ID

After the EPROM(s) are marked they should be placed in conductive IC carriers and securely packed. Do not use styrofoam

VERIFICATION MEDIA

All original pattern media (EPROMs or Floppy Disk) are filed for contractual purposes and are not returned. A computer listing of the ROM code will be generated and returned along with a listing verification form. The listing should be

thoroughly checked and the verification form completed, signed, and returned to Motorola. The signed verification form constitutes the contractual agreement for creation of the customer mask. If desired, Motorola will program one blank EPROM from the data file used to create the custom mask to aid in the verification process.

ROM VERIFICATION UNITS (RVUs)

Ten MCUs containing the customer's ROM pattern will be sent for program verification. These units will have been made using the custom mask but are for the purpose of ROM verification only. For expediency they are usually unmarked, packaged in ceramic, and tested only at room temperature and 5 volts. These RVUs are included in the mask charge and are not production parts. The RVUs thus are not guaranteed by Motorola Quality Assurance, and should be discarded after verification is completed.

FLEXIBLE DISKS

The disk media submitted must be single-sided, single-density, 8-inch, MDOS-compatible floppies. The customer must write the binary file name and company name on the disk with a felt-tip pen. The minimum MDOS system files as well as the absolute binary object file (filename, LO type of file) from the M6805 cross assembler must be on the disk. An object file made from a memory dump using the ROLLOUT command is also acceptable. Consider submitting a source listing as well as the following files. filename, .LX(EXORciser® loadable format) and filename, .SA (ASCII Source Code). These files will of course be kept confidential and are used 1) to speed up the process in-house if any problems arise, and 2) to speed up the user-to-factory interface if the user finds any software errors and needs assistance quickly from Motorola factory representatives.

MDOS is Motorola's Disk Operating System available on development systems such as EXORciser, EXORsets, etc.

MC6805T2 MCU ORDERING INFORMATION

| Address | | | MC | |
|---------------|---|---|--|-----------------------|
| | | | sc | Zip |
| • | | | | ΖΙΡ |
| Country | | | | |
| Phone | | Extension | | |
| Customer Con | tact Person | | | |
| Customer Part | Number | | | |
| | | otions for your MCU from | | |
| | Timer Clock Source ☐ Internal ¢2 clock ☐ TIMER input pin | | | |
| | Timer Prescaler 2º (divide by 1) 2¹ (divide by 2) 2² (divide by 4) 2³ (divide by 8) | 2* (divide by 16) 25 (divide by 32) 26 (divide by 64) 27 (divide by 128) | | |
| | Internal Oscillator Input Crystal Resistor | Low Voltage Inhibit P Disable Enable | ort A Output Drive CMOS and TTL TTL Only | - |
| Pattern | Media (All other media requir | res prior factory approval) | | |
| | ☐ EPROMs (MCM27 | 716 or MCM2532 | ☐ Floppy Disk | |
| | | | Other | |
| Clock Freg | | | | |
| • | | | tandard) □ -40° t | to +85°C* □ -40° to - |
| | or factory approval | | | |
| | nation (12 Characters Maximu | m) | | |
| | | | | |



MC6805U2

Advance Information

8-BIT MICROCOMPUTER UNIT WITH A/D

The MC6805R2 Microcomputer Unit (MCU) is a member of the M6805 Family of low-cost single-chip Microcomputers. The 8-bit microcomputer contains a CPU, on-chip CLOCK, ROM, RAM, I/O, 4-channel 8-bit A/D, and TIMER. It is designed for the user who needs an economical microcomputer with the proven capabilities of the M6800-based instruction set. A comparison of the key features of several members of the M6805 Family of microcomputers is shown on the last page of this data sheet. The following are some of the hardware and software highlights of the MC6805R2 MCU.

HARDWARE FEATURES:

- 8-Bit Architecture
- 64 Bytes of RAM
- Memory Mapped I/O
- 2048 Bytes of User ROM
- 24 TTL/CMOS Compatible Bidirectional I/O Lines (8 lines are LED Compatible)
- 2 to 5 Digital Input Lines
- A/D Converter
 - 8-Bit Conversion, Monotonic
 - 1 to 4 Multiplexed Analog Inputs
 - ± 1/2 LSB Quantizing Error
 - ± 1/2 LSB All Other Errors
 - ± 1 LSB Total Error (max)
 - Ratiometric Conversion
- Zero-Crossing Detection
- On-Chip Clock Generator
- Self-Check Mode
- Master Reset
- Complete Development System Support On EXORciser®
- 5 V Single Supply

SOFTWARE FEATURES:

- Similar to M6800 Family
- Byte Efficient Instruction Set
- Easy to Program
- True Bit Manipulation
- Bit Test and Branch Instructions
- Versatile Interrup Handling
- Versatile Index Register
- Powerful Indexed Addressing for Tables
- Full Set of Conditional Branches
- Memory Usable as Register/Flags
- Single Instruction Memory Examine/Change
- 10 Powerful Addressing Modes
- All Addressing Modes
- User Callable Self-Check Subroutines

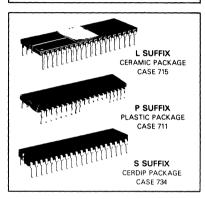
USER SELECTABLE OPTIONS:

- Internal 8-Bit Timer with Selectable Clock Source (External Timer Input or Internal Machine Clock)
- Timer Prescaler Option (7 Bits 2N)
- 8 Bidirectional I/O Lines with TTL or TTL/CMOS Interface Option
- Crystal or Low-Cost Resistor Oscillator Option
- Low Voltage Inhibit Option ,
- 4 Vectored Interrupts, Timer, Software, and 2 External

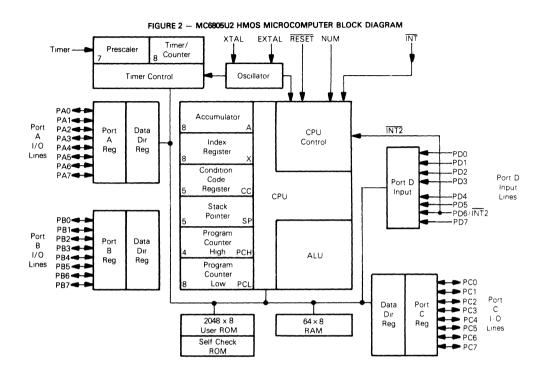
HMOS

(HIGH DENSITY N-CHANNEL, SILICON-GATE DEPLETION LOAD)

8-BIT MICROCOMPUTER



| VSSET 1 • RESET 1 2 INT 1 3 | 40]PA7 39]PA6 38]PA5 |
|---|-------------------------------|
| VCC [4 EXTAL [5 XTAL [6 | 37 |
| NUM . 7 | 34 1 PA1 |
| TIMER . 8 | 33 1 PA0 |
| PCO . 9 | 32 1 PB7 |
| PC1 [] 10 | 31 1 PB6 |
| PC2 [] 11 | 30 1 PB5 |
| PC3 [] 12 | 29 1 PB4 |
| PC4 [13 | 28 PB3 |
| PC5 [14 | 27 PB2 |
| PC6 [15 | 26 PB1 |
| PC7 0 16 | 25 1 PB0 |
| PD7 0 17 | 24 1 PD0 |
| PD6/INT2 0 18 | 23 1 PD1 |
| PD5 0 19 | 22 1 PD2 |
| PD4 0 20 | 21 1 PD3 |



MAXIMUM RATINGS

| Rating | Symbol | Value | Unit |
|---|------------------|-------------------|------|
| Supply Voltage | Vcc | -03 to +70 | V |
| Input Voltage (Except Pin 6) | V _{in} | -03 to +70 | V |
| Operating Temperature Range | TA | 0 to 70 | °C |
| Storage Temperature Range | ⊤ _{stg} | -55 to +150 | °C |
| Junction Temperature Plastic Ceramic Cerdip | ŢJ | 150 175 175 | °C |

This device contains circuitry to protect the inputs against damage due to high static voltages or electric fields, however, it is advised that normal precautions be taken to avoid application of any voltage higher than maximum rated voltages to this high-impedance circuit. For proper operation it is recommended that V_{1D} and V_{OUI} be constrained to the range $V_{SS}\!\leq\!iV_{1D}$ or $V_{OUI}\!\leq\!vC_{C}$. Reliability of operation is enhanced if unused inputs are tied to an appropriate logic voltage level i.e. g, either V_{SS} or V_{CC}

THERMAL CHARACTERISTICS

| Characteristic | Symbol | Value | Unit |
|--------------------|---------------|-------|------|
| Thermal Resistance | | | |
| Plastic | | 100 | |
| Ceramic | θ_{JA} | 50 | °C/W |
| Cerdip | | 60 | |

POWER CONSIDERATIONS

The average chip-junction temperature, T_J, in °C can be obtained from:

$$T_{J} = T_{A} + (P_{D} \bullet \theta_{JA})$$
Where:

T_A = Ambient Temperature, °C

 θ_{JA} = Package Thermal Resistance, Junction-to-Ambient, °C/W

PD = PINT + PPORT

PINT≡ICC×VCC, Watts - Chip Internal Power

PPORT = Port Power Dissipation, Watts - User Determined

For most applications PPORT ◀PINT and can be neglected. PPORT may become significant if the device is configured to drive Darlington bases or sink LED loads.

An approximate relationship between PD and TJ (if PPORT is neglected) is:

 $P_D = K + (T_1 + 273 ^{\circ}C)$

Solving equations 1 and 2 for K gives

 $K = P_D \bullet (T_A + 273 \circ C) + \theta_{JA} \bullet P_D^2$

(3)

(2)

Where K is a constant pertaining to the particular part. K can be determined from equation 3 by measuring PD (at equilibrium) for a known TA. Using this value of K the values of PD and TJ can be obtained by solving equations (1) and (2) iteratively for any value of TA.

ELECTRICAL CHARACTERISTICS (V_{CC}= +5 25 Vdc ±0 5 Vdc, V_{SS}= GND, T_A=0° to 70°C Unless Otherwise Noted)

| Characteristic | Symbol | Min | Тур | Max | Unit |
|---|------------------|--|-----------------------------|----------------------------------|---------------------|
| Input High Voltage RESET (4 75≤V _{CC} ≤5 75) (V _{CC} <4 75) INT (4 75≤V _{CC} ≤5 75) (V _{CC} <4 75) All Other | VIH | 40 V _{CC} -05 40 V _{CC} -05 20 | - * * | Vcc Vcc Vcc Vcc Vcc | ٧ |
| Input High Voltage Timer Timer Mode Self-Check Mode | ٧١٢ | 2 0 — | _ 9 0 | V _{CC} | V |
| Input Low Voltage RESET INT All Other | VIL | -03 -03 -03 | - * - | 0 8 1 5 0 8 | ٧ |
| RESET Hysteresis Voltages (See Figures 11, 12, and 13) "Out of Reset" "Into Reset" | VIRES+ VIRES- | 2 1 0 8 | _ | 4 0 2 0 | ٧ |
| INT Zero Crossing Voltage, Through a Capacitor | VINT | 2 | _ | 4 | V _{ac p-p} |
| Internal Power Dissipation, No Port Loading $V_{CC} = 5.75 \text{ V}$, $T_A = 0^{\circ}\text{C}$ | PINT | | 600 | _ | mW |
| Input Capacitance EXTAL All Other | C _{in} | <u>-</u> - | 25 10 | | pF |
| Low Voltage Recover | V _{LVR} | - | _ | 4 75 | V |
| Low Voltage Inhibit | VLVI | _ | 35 | _ | V |
| Input Current TIMER ($V_{In} = 0.4 \text{ V}$) $\overline{\text{INT}} (V_{In} = 2.4 \text{ V to V}_{CC})$ EXTAL ($V_{In} = 2.4 \text{ V to V}_{CC}$ Crystal Option) $\overline{\text{(V_{In} = 0.4 \text{ V Crystal Option)}}}$ $\overline{\text{RESET}} (V_{In} = 0.8 \text{ V})$ (External Capacitor Charging Current) | l _{II} | - - - - -4 0 | _ 20 _ _ _ _ | 20 50 10 - 1600 - 50 | μΑ |

^{*} Due to internal biasing, this input (when unused) floats to approximately 2 0 V

 $\textbf{SWITCHING CHARACTERISTICS} \ (\text{V}_{CC} = +5\ 25\ \text{Vdc} \ \pm 0\ 5\ \text{Vdc}, \ \text{V}_{SS} = \text{GND}, \ \text{T}_{A} = 0^{\circ} \ \text{to} \ \ \underline{70^{\circ}\text{C}} \ \text{Unless Otherwise Noted})$

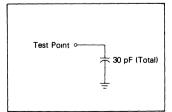
| Characteristic | Symbol | Min | Тур | Max | Unit |
|--|------------------|------------------------|-----|-----|------|
| Oscillator Frequency | fosc | 0 4 | _ | 4 2 | MHz |
| Cycle Time (4/f _{osc}) | t _{cyc} | 0 95 | _ | 10 | μS |
| INT and TIMER Pulse Width | tWL, tWH | t _{cyc} + 250 | _ | - | ns |
| RESET Pulse Width | tRWL | t _{cyc} + 250 | - | _ | ns |
| RESET Delay Time (External Cap=1 μF) | ^t RHL | | 100 | - | ms |
| INT Zero Crossing Detection Input Frequency (for ±5° Accuracy) | fINT | 0 03 | _ | 10 | kHz |
| External Clock Input Duty Cycle (EXTAL) | _ | 40 | 50 | 60 | % |

PORT ELECTRICAL CHARACTERISTICS (VCC = +5.25 Vdc ±0.5 Vdc, VSS = GND, TA = 0° to 70° C Unless Otherwise Noted)

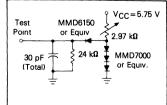
| Characteristic | Symbol | Min | Тур | Max | Unit |
|--|-----------------------|-----|-----|------|------|
| Port A with CN | IOS drive enabled | | | | |
| Output Low Voltage ILoad = 1 6 mA | VOL | _ | | 0 4 | V |
| Output High Voltage I _{Load} = -100 μA | Voн | 2 4 | - | _ | V |
| Output High Voltage I _{Load} = -10 μA | Voн | 3 5 | _ | _ | V |
| Input High Voltage I _{Load} = -300 µA (max) | V _{IH} | 20 | _ | VCC | V |
| Input Low Voltage $I_{Load} = -500 \mu A$ (max) | ۷۱۲ | -03 | _ | 0.8 | V |
| Hi-Z State Input Current (V _{In} =20 V to V _{CC}) | JiH | _ | - | -300 | μΑ |
| Hi-Z State Input Current (V _{In} =0 4 V) | ווּ | _ | _ | -500 | μΑ |
| Po | ort B | | | | |
| Output Low Voltage ILoad=3 2 mA | VOL | 1 | - | 0 4 | ٧ |
| Output Low Voltage ILoad= 10 mA (sink) | VOL | _ | _ | 10 | V |
| Output High Voltage $I_{Load} = -200 \mu A$ | Voн | 2 4 | _ | _ | V |
| Darlington Current Drive (Source) V _O = 1 5 V | ЮН | -10 | | 10 | mA |
| Input High Voltage | V _{IH} | 2 0 | | Vcc | V |
| Input Low Voltage | VIL | -03 | | 0.8 | ٧ |
| Hı-Z State Input Current | ^I TSI | - | 2 | 20 | μΑ |
| | h CMOS drive disabled | | | | |
| Output Low Voltage I _{Load} = 1 6 mA | VOL | | | 0 4 | V |
| Output High Voltage I _{Load} = -100 μA | V _{OH} | 2 4 | | | V |
| Input High Voltage | V _{IH} | 2 0 | _ | Vcc | V |
| Input Low Voltage | ٧١٢ | -03 | _ | 0.8 | V |
| Hı-Z State Input Current | ^I TSI | | 2 | 20 | μΑ |
| Port D | (Inputs) | | | | |
| Input High Voltage | V _{IH} | 20 | - | Vcc | ٧ |
| Input Low Voltage | V _{IL} | -03 | | 0.8 | V |
| Input Current | In | _ | _ | 20 | μΑ |

FIGURE 3 - TTL EQUIVALENT TEST LOAD FIGURE 4 - CMOS EQUIVALENT TEST LOAD FIGURE 5 - TTL EQUIVALENT TEST LOAD (PORT B) (PORT A)

 $V_{CC} = 5.75 \text{ V}$ MMD6150 Test or Equiv Point 40 pF 2 MMD7000 or Equiv 12 k Ω (Total)



(PORTS A AND C)



SIGNAL DESCRIPTION

The input and output signals for the MCU, shown in Figure 1, are described in the following paragraphs

VCC AND VSS — Power is supplied to the MCU using these two pins VCC is power and VSS is the ground connection

INT — This pin provides the capability for asynchronously applying an external interrupt to the MCU Refer to INTER-RUPTS for additional information

XTAL AND EXTAL — These pins provide control input for the on-chip clock oscillator circuit. A crystal, a resistor, or an external signal depending on user selectable manufacturing mask option, can be connected to these pins to provide a system clock with various degrees of stability/cost tradeoffs Lead length and stray capacitance on these two pins should be minimized. Refer to INTERNAL CLOCK GENERATOR OPTIONS for recommendations about these inputs

TIMER – This pin allows an external input to be used to decrement the internal timer circuitry. Refer to TIMER for additional information about the timer circuitry.

RESET — This pin allows resetting of the MCU at times other than the automatic resetting capability already in the MCU. The MCU can be reset by pulling RESET low. Refer to RESETS for additional information.

NUM (Non-User Mode) — This pin is not for user application and must be connected to V_{SS}

INPUT/OUTPUT LINES (PA0-PA7, PB0-PB7, PC0-PC7, PD0-PD7) — These 32 lines are arranged into four 8-bit ports (A, B, C, and D) Ports A, B, and C are programmable as either inputs or outputs, under software control of the data direction registers Port D is for digital input only and bit 6 may be used for a second interrupt INT2 Refer to INPUT/OUTPUT and INTERRUPTS for additional informa-

MEMORY — The MCU is capable of addressing 4096 bytes of memory and I/O registers with its program counter. The MC6805U2 MCU has implemented 2314 of these bytes. This consists of 2048 user ROM bytes, 192 self-check ROM bytes, 64 user RAM bytes, 7 port I/O bytes, 2 timer registers, and a miscellaneous register, see Figure 6 for the Address Map. The user ROM has been split into three areas. The first area is memory locations \$080 to \$0FF, and allows the user to access the ROM locations utilizing the direct and table look-up indexed addressing modes. The main user ROM area is from \$7C0 to \$F37. The last 8 user ROM locations at the top of memory are for the interrupt vectors.

The MCU reserves the first 16 memory locations for I/O features, of which 10 have been implemented. These locations are used for the ports, the port DDRs, the timer, and the $\overline{\text{INT2}}$ miscellaneous register. Of the 64 RAM bytes, 31 bytes are shared with the stack area. The stack must be used with care when data shares the stack area.

The shared stack area is used during the processing of interrupt and subroutine calls to save the processor state

\$07F

5 4 3 2 1 000 \$000 I/O Ports \$000 Port A Data Timer \$001 Page Zero Port B Data RAM Access with (128 Bytes) Port C Data \$002 127 \$07F Short 128 \$080 Port D Data \$003 3 Instructions Page-Zero User ROM Port A DDR* \$004* Δ (128 Bytes) 5 Port B DDR* \$005* 255 256 SOFF \$100 Port C DDR* \$006* 6 Not Used Not Used \$007 (1728 Bytes) 8 Timer Data Reg \$008 \$7RF 1983 \$7C0 Timer Control Rea 9 \$009 Main User SOOA ROM 10 Misc Reg (1912 Bytes) 11 SOOR 3895 3896 SF 37 Not Used SF38 Self-Check (53 Bytes) ROM 63 \$03F (192 Bytes) \$040 64 4087 SFF RAM 4088 SFFR Interrupt (64 Bytes) Vectors ROM Stack (8 Bytes) (31 Bytes Maximum)

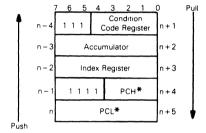
FIGURE 6 -- MC6805U2 MCU ADDRESS MAP

tion

^{*}Caution Data Direction Registers (DDRs) are write-only, they read as \$FF

The register contents are pushed onto the stack in the order shown in Figure 7. Since the Stack Pointer decrements during pushes, the low order byte (PCL) of the Program Counter is stacked first, then the high order four bits (PCH) are stacked. This ensures that the program counter is loaded correctly during pulls from the stack since the stack pointer increments when it pulls data from the stack. A subroutine call results in only the Program Counter (PCL, PCH) contents being pushed onto the stack, the remaining CPU registers are not pushed.

FIGURE 7 - INTERRUPT STACKING ORDER



*For subroutine calls, only PCH and PCL are stacked

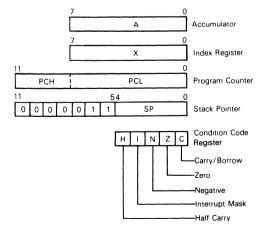
CENTRAL PROCESSING UNIT

The CPU of the M6805 Family is implemented independently from the I/O or memory configuration. Consequently, it can be treated as an independent central processor communicating with I/O and memory via internal address, data, and control buses.

REGISTERS

The M6805 Family CPU has five registers available to the programmer. They are shown in Figure 8 and are explained in the following paragraphs.

FIGURE 8 - PROGRAMMING MODEL



ACCUMULATOR (A) — The Accumulator is a general purpose 8-bit register used to hold operands and results of arithmetic calculations or data manipulations.

INDEX REGISTER (X) — The Index Register is an 8-bit register used for the indexed addressing mode. It contains an 8-bit value that may be added to an instruction value to create an effective address. The index register can also be used for data manipulations using the read/modify/write instructions. The Index Register may also be used as a temporary storage area.

PROGRAM COUNTER (PC) — The Program Counter is a 12-bit register that contains the address of the next instruction to be executed

STACK POINTER (SP) — The Stack Pointer is a 12-bit register that contains the address of the next free location on the stack During an MCU reset, or the Reset Stack Pointer (RSP) instruction, the Stack Pointer is set to location \$07F. The Stack Pointer is then decremented as data is pushed onto the stack and incremented as data is then pulled from the stack. The seven most-significant bits of the Stack Pointer are permanently set to 0000011. Subroutines and interrupts may be nested down to location \$061 (31 bytes maximum) which allows the programmer to use up to 15 levels of subroutine calls (less if interrupts are allowed).

CONDITION CODE REGISTERS (CC) — The Condition Code Register is a 5-bit register in which four bits are used to indicate the results of the instruction just executed. These bits can be individually tested by a program and specific action taken as a result of their state. Each bit is explained in the following paragraphs.

Half Carry (H) — Set during ADD and ADC operations to indicate that a carry occurred between bits 3 and 4

Interrupt (I) — When this bit is set, the timer and external interrupts ($\overline{\text{INT}}$ and $\overline{\text{INT2}}$) are masked (disabled). If an interrupt occurs while this bit is set, the interrupt is latched and is processed as soon as the interrupt bit is cleared.

Negative (N) — When set, this bit indicates that the result of the last arithmetic, logical, or data manipulation was negative (bit 7 in the result is a logical one)

 $\mbox{\bf Zero}$ (Z) - When set, this bit indicates that the result of the last arithmetic, logical, or data manipulation was zero

Carry/Borrow (C) — When set, this bit indicates that a carry or borrow out of the Arithmetic Logic Unit (ALU) occurred during the last anthmetic operation. This bit is also affected during bit test and branch instructions plus shifts and rotates.

TIMER

The MC6805U2 MCU timer circuitry is shown in Figure 9 The 8-bit counter may be loaded under program control and is decremented toward zero by the clock input (or prescaler output) When the timer reaches zero, the timer interrupt request bit (bit 7) in the Timer Control Register (TCR) is set The timer interrupt can be masked (disabled) by setting the timer interrupt mask bit (bit 6) in the TCR. The interrupt bit (I-bit) in the Condition Code Register also prevents a timer interrupt from being processed. The MCU responds to this interrupt by saving the present CPU state in the stack, fetching the timer interrupt vector from locations \$FF8 and \$FF9 and executing the interrupt routine (see the INTER-RUPT section) THE TIMER INTERRUPT REQUEST BIT MUST BE CLEARED BY SOFTWARE The timer and INT2 share the same interrupt vector THE INTERRUPT ROUTINE MUST CHECK THE REQUEST BITS TO DETERMINE THE SOURCE OF THE INTERRUPT

The clock input to the timer can be from an external source (decrementing of Timer Counter occurs on a positive transition of the external source) applied to the TIMER input pin, or it can be the internal $\phi 2$ signal. When the $\phi 2$ signal is

used as the source, it can be gated by an input applied to the TIMER input pin allowing the user to easily perform pulse-width measurements (NOTE For ungated $\phi 2$ clock input to the timer prescaler, the TIMER pin should be tied to VCC) The source of the clock input is one of the mask options that is specified before manufacture of the MCU

A prescaler option can be applied to the clock input that extends the timing interval up to a maximum of 128 counts before decrementing the counter. This prescaling mask option is also specified before manufacture. To avoid truncation errors, the prescaler is cleared when bit 3 of Timer Control Register is written to a logic 1 (this bit always reads as a logic 0).

The timer continues to count past zero, falling through to \$FF from zero and then continuing the count. Thus, the counter can be read at any time by reading the Timer Data Register (TDR). This allows a program to determine the length of time since a timer interrupt has occurred, and not disturb the counting process.

At power-up or reset, the prescaler and counter are initialized with all logical ones, the timer interrupt request bit (bit 7) is cleared and the timer interrupt mask bit (bit 6) is set

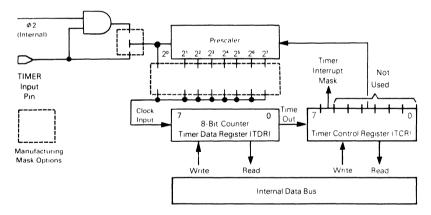


FIGURE 9 - TIMER BLOCK DIAGRAM

SELF-CHECK

The self-check capability of the MC6805U2 MCU provides an internal check to determine if the part if functional Connect the MCU as shown in Figure 10 and monitor the output of Port C bit 3 for an oscillation of approximately 7 Hz A 9 volt level on the TIMER input, pin 8, energizes the ROMbased self-check feature. The self-check program exercises the RAM, ROM, timer, interrupts, and I/O ports

Two of the self-check subroutines (the RAM and ROM tests) can be called by a user program with a JSR or BSR instruction. The timer routine may also be called if the timer input is the internal \$\phi 2\$ clock.

RAM SELF-CHECK SUBROUTINE — The RAM self-check is called at location \$F6F and returns with the Z-bit

clear if any error is detected, otherwise the Z-bit is set. The walking diagnostic pattern method is used.

The RAM test must be called with the stack pointer at \$07F When run, the test checks every RAM cell except for \$07F and \$07E which are assumed to contain the return address

The A and X registers and all RAM locations except the top two are modified

ROM CHECKSUM SUBROUTINE — The ROM self-check is called at location \$F8A and returns with the Z-bit cleared if any error was found, otherwise Z=1 X=0 on return, and A is zero if the test passed RAM locations \$040-\$043 are overwritten. The checksum is the compliment of the exclusive OR of the contents of the user ROM

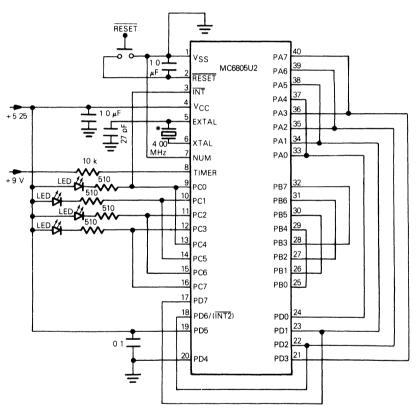
TIMER SELF-CHECK SUBROUTINE — The timer self-check is called at location FCF and returns with the Z-bit cleared if any error was found, otherwise Z=1

In order to work correctly as a user subroutine, the internal $\phi 2$ clock must be the clocking source and interrupts must be disabled. Also, on exit, the clock is running and the interrupt mask not set so the caller must protect from interrupts if

necessary

The A and X register contents are lost. The timer self-check routine counts how many times the clock counts in 128 cycles. The number of counts should be a power of two since the prescaler is a power of two. If not, the timer probably is not counting correctly. The routine also detects a timer which is not running.

FIGURE 10 - SELF-CHECK CONNECTIONS



^{*}This connection depends on clock oscillator user selectable mask option. Use jumper if the RC mask option is selected

| LED Meanings | | | | | | | |
|--------------|--------------|----|---|--------------------------------|--|--|--|
| C0 | C1 | C2 | ឌ | Remarks [1:LED ON; 0:LED OFF] | | | |
| 1 | 0 | 1 | 0 | Bad I/O | | | |
| 0 | 0 | 1 | 0 | Bad Timer | | | |
| 1 1 | 1 | 0 | 0 | Bad RAM | | | |
| 0 | 1 | 0 | 0 | Bad ROM | | | |
| 1 | 0 | 0 | 0 | Bad A/D | | | |
| 0 | 0 | 0 | 0 | Bad Interrupts or Request Flag | | | |
| | All Flashing | | | Good Part | | | |

Anything else bad Part, Bad Port 3, Bad ISP, etc

RESETS

The MCU can be reset three ways by initial power-up, by the external reset input (RESET), and by an optional internal low-voltage detect circuit, see Figure 11. The internal circuit connected to the $\overline{\text{RESET}}$ pin consists of a Schmitt trigger which senses the $\overline{\text{RESET}}$ line logic level. The Schmitt trigger provides an internal reset voltage it if senses a logical 0 on the RESET pin. During power-up, the Schmitt trigger switches on (removes reset) when the $\overline{\text{RESET}}$ pin voltage rises to VIRES+. When the $\overline{\text{RESET}}$ pin voltage falls to a logical 0 for a period longer than one t_{CYC} , the Schmitt trigger switches off to provide an internal reset voltage. The "switch off" voltage occurs at VIRES — A typical reset Schmitt trigger hysteresis curve is shown in Figure 12.

Upon power-up, <u>a delay</u> of t_{RHL} milliseconds is needed before allowing the \overline{RESET} input to go high. This time allows the internal clock generator to stabilize. Connecting a capacitor to the \overline{RESET} input as shown in Figure 13 typically

provides sufficient delay See Figure 17 for the complete reset sequence

INTERNAL CLOCK GENERATOR OPTIONS

The internal clock generator circuit is designed to require a minimum of external components. A crystal, a resistor, a jumper wire, or an external signal may be used to control the internal clock generator with various stability/cost tradeoffs. A manufacturing mask option is used to select the crystal or resistor option. The oscillator frequency is internally divided by four to produce the internal system clocks.

The different connection methods are shown in Figure 14. The Crystal specifications are given in Figure 15. A resistor selection graph is shown in Figure 16.

The crystal oscillator start-up time is a function of many variables crystal parameters (especially Rs) oscillator load capacitances, IC parameters, ambient temperatures, supply voltage, and supply voltage turn-on time. To ensure rapid oscillator start-up, neither the crystal characteristics nor the load capacitances should exceed recommendations.

FIGURE 11 - POWER AND RESET TIMING

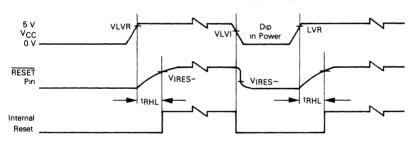


FIGURE 12 — TYPICAL RESET SCHMITT TRIGGER HYSTERESIS

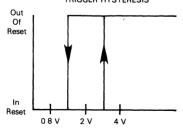


FIGURE 13 - POWER UP RESET DELAY CIRCUIT

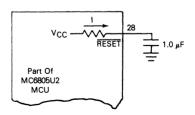
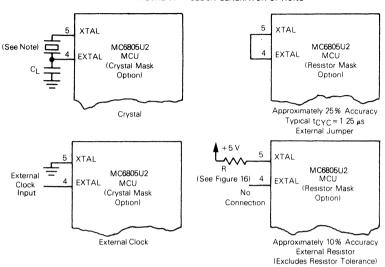


FIGURE 14 - CLOCK GENERATOR OPTIONS



NOTE The recommended C_L value with a 4.0 MHz crystal is 27 pF, maximum, including system distributed capacitance. There is an internal capacitance of approximately 25 pF on the XTAL pin. For crystal frequencies other than 4 MHz, the total capacitance on each pin should be scalled as the inverse of the frequency ratio. For example, with a 2 MHz crystal, use approximately 50 pF on EXTAL and approximately 25 pF on XTAL. The exact value depends on the Motional-Arm parameters of the crystal used.

FIGURE 15 - CRYSTAL MOTIONAL ARM PARAMETERS

Crystal Motional Arm Equivalent Parameters EXTAL 5 CO AND SUGGESTED PC BOARD LAYOUT C1 RS XTAL 6

AT — Cut Parallel Resonance Crystal

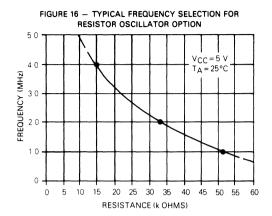
Co = 7 pF Max
FRE0 = 4 0 MHz @ Ct = 24 pF
RS = 50 ohms Max

CRYSTAL

CRYSTAL

MCU

Note Keep crystal leads and circuit connections as short as possible

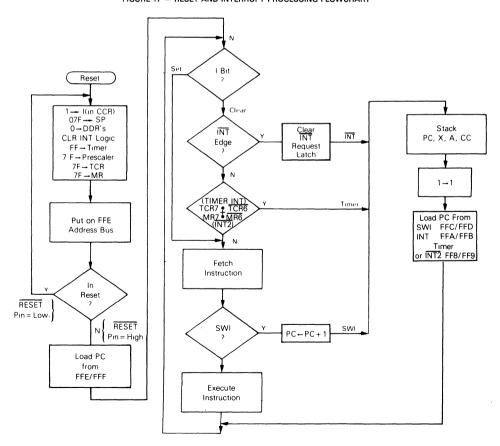


INTERRUPTS

The MC6805U2 MCU can be interrupted four different ways through the external interrupt (INT) input pin, the internal timer interrupt request, the external port D bit 6 (INT2) input pin, and a software interrupt instruction (SWI). When any interrupt occurs, processing is suspended, the present CPU state is pushed onto the stack, the interrupt bit (I-bit) in the Condition Code Register is set, the address of the interrupt routine is obtained from the appropriate interrupt vector address, and the interrupt routine is executed Stacking the CPU registers, setting the I-bit and vector fetching requires a total of 11 $t_{\rm CVC}$ periods for completion

Refer to Figure 17 for a flowchart The interrupt service routines must end with a Return from Interrupt (RTI) instruction which allows the MCU to resume processing of the program prior to the interrupt Table 1 provides a listing of the interrupts, their priority, and the address of the vector which

FIGURE 17 - RESET AND INTERRUPT PROCESSING FLOWCHART



contains the starting address of the appropriate interrupt service routine. The interrupt priority applies to those pending when the CPU is ready to accept an interrupt or a new interrupt. RESET is listed in Table 1 because it is processed similiar to an interrupt. However, it is not normally used as an interrupt. When the interrupt mask bit in the Condition Code Register is set the interrupt is latched for later interrupt execution.

NOTE

The timer and $\overline{\text{INT2}}$ share the same vector address. The interrupt routine must determine the source by examining the interrupt request bits (TCR7 and MR7). Both TCR7 and MR7 can only be written to 0 by software.

The external interrupts, $\overline{\text{INT}}$ and $\overline{\text{INT2}}$, are set on the falling edge of the input signal. The $\overline{\text{INT2}}$ has an interrupt re-

quest bit (bit 7) and a mask bit (bit 6) located in the Miscellaneous Register (MR), refer to Figure 18. The $\overline{INT2}$ interrupt is inhibited when the mask bit is set. The $\overline{INT2}$ is always readable as a digital input of Port D. The $\overline{INT2}$ and timer interrupt request bits, it set, causes the MCU to process an interrupt when the condition code l-bit is clear

TABLE 1 - INTERRUPT PRIORITIES

| Interrupt | Priority | Vector Address |
|------------|----------|-----------------|
| RESET | 1 | \$FFE and \$FFF |
| SWI | 2* | \$FFC and \$FFD |
| INT | 3 | \$FFA and \$FFB |
| TIMER/INT2 | 4 | \$FF8 and \$FF9 |

^{*} Priority 2 applies when the I-bit in the Condition Code Register is set. When I = 0, SWI has a priority of 4, like any other instruction, the priority of INT thus becomes 2 and the timer becomes 3.

FIGURE 18 - MCU REGISTER CONFIGURATION

(1) Write Only, reads as all 1's (2) 1= Output, 0= Input Cleared to 0 by Reset (3) Port A Addr=\$004 Port B Addr=\$005 Port C Addr=\$006 Port D Addr=None, Port D is input only PORT DATA REGISTER 7 0 Port A Addr=\$000

Port B Addr = \$001 Port C Addr = \$002

PORT DATA DIRECTION REGISTER (DDR)

7 6 5 4 3 2 1 0 1 1 1 1 1 1 1 1 5009 TCR7—Timer Interrupt Request Status Bit Set when TDR coes to zero, must be cleared by software.

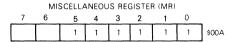
TDR goes to zero, must be cleared by software
Cleared to 0 by Reset

TCR6—Timer Interrupt Mask Bit 1= timer interrupt masked (disabled) Set to 1 by Reset

TCR3 – Clear Prescaler Always reads as a 0, clears prescaler when written to a logic 1

TCR Bits 5, 4, 2, 1, 0 reads 1's - unused bits





MR7 Bit 7 – $\overline{\text{INT2}}$ Interrupt Request Bit Set when falling edge detected on $\overline{\text{INT2}}$ pin, must be cleared by software Cleared to 0 by Reset MR6 Bit 6 – $\overline{\text{INT2}}$ Interrupt Mask Bit 1 = $\overline{\text{INT2}}$ Interrupt masked (disabled) Set to 1 by Reset MR Bits 5, 4, 3, 2,1 0 – Read as 1's – unused bits

A sinusoidal input signal ($f_{|NT|}$ maximum) can be used to operate an external interrupt (\overline{INT}), as shown in Figure 19, for use as a Zero-Crossing Detector with hysteresis included An interrupt request is generated for each negative-slope, zero crossing of the AC signal. For digital applications, the \overline{INT} can be driven directly by a digital signal at a maximum period of t_{IWL} . This allows applications such as servicing time-of-day routines and engaging/disengaging AC power control devices. Off-chip full wave rectification provides an interrupt at every zero crossing of the AC signal and thereby provide a 2f clock.

A software interrupt (SWI) is an executable instruction which is executed regardless of the state of the I-bit in the Condition Code Register SWI s are usually used as breakpoints for debugging or as system calls

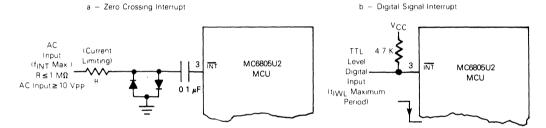
INPUT/OUTPUT

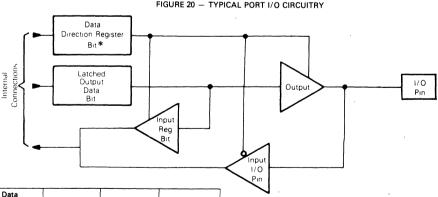
There are 32 input or input/output pins. The INT pin may also be polled with branch instructions to provide an addi-

tional input pin. All pins on ports A, B, and C are programmable as either inputs or outputs under software control of the corresponding Data Direction Registers (DDRs). The port I/O programming is accomplished by setting the corresponding bit in the port DDR to a logic "1" for output or a logic "0" for input. On reset all the DDRs are initialized to a logic "0" state, placing the ports in the input mode. The port output registers are not initialized on reset and should be initialized by software before changing the DDRs from input to output. When programmed as outputs, all I/O pins read latched output data, regardless of the logic levels at the output pin due to output loading, refer to Figure 20.

All input/output lines are TTL compatible as both inputs and outputs. Port A lines are CMOS compatible as outputs using a mask option. Port B, C, and D lines are CMOS compatible as inputs. Port D lines are input only, thus, there is no corresponding DDR. When programmed as outputs, Port B is capable of sinking. 10 milliamperes and sourcing. 1.0 milliampere on each pin.

FIGURE 19 - TYPICAL INTERRUPT CIRCUITS





Direction Output Input Register Data Output Tο Bit Bit State MCU 0 0 0 1 1 3-State** 0 Pin Х

* DDR is a write-only register and reads as all 1's

**Ports A (with CMOS drive disabled), B, and C are three-state ports. Port A has optional internal pullup devices to provide CMOS drive capability. See Electrical Characteristics tables for complete information.

Figure 21 provides some examples of port connections. The Address Map in Figure 6 gives the addresses of data registers and DDRs. The Register Configuration is provided in Figure 18

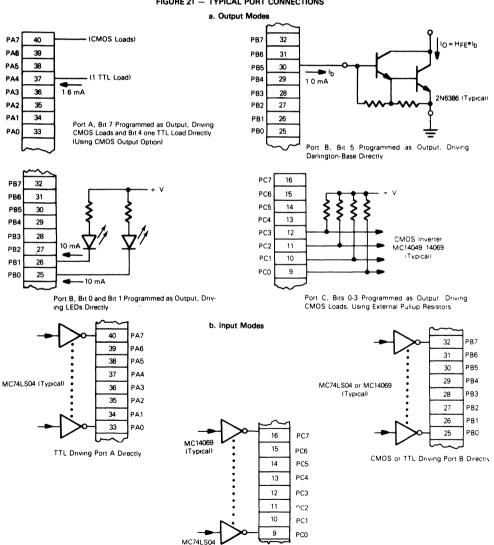
CAUTION

The corresponding DDRs for Ports A, B, and C are write-only registers (locations \$004, \$005, and \$006). A read operation on these registers is undefined. Since BSET and BCLR are read/modify/write functions, they cannot be used to set or clear a DDR bit (all "unaffected"

bits would be set). It is recommended that all DDR bits in a port be written using a single-store instruction.

The latched output data bit (see Figure 18) may always be written Therefore, any write to a port writes all of its data bits even though the port DDR is set to input. This may be used to initialize the data registers and avoid undefined outputs However, care must be exercised when using read/modify/write instructions since the data read corresponds to the pin level if the DDR is an input (0) and corresponds to the latched output data when the DDr is an output (1)

FIGURE 21 - TYPICAL PORT CONNECTIONS



CMOS and TTL Driving Port C Directly

(Typical)

BIT MANIPULATION

The MC6805U2 MCU has the ability to set or clear any single RAM or input/output bit (except the Data Direction Registers, see Caution under INPUT/OUTPUT paragraph) with a single instruction (BSET, BCLR). Any bit in page zero including ROM, except the DDRs, can be tested using the BRSET and BRCLR instructions and the program branches as a result of its state. The carry bit (C) equals the value of the bit referenced by BRSET and BRCLR. The capability to work with any bit in RAM, ROM, or I/O allows the user to have individual flags in RAM or to handle single I/O bits as

control lines

The coding example in Figure 22 illustrates the usefulness of the bit manipulation and test instructions. Assume that the MCU is to communicate with an external serial device. The external device has a data ready signal, a data output line, and a clock line to clock data one bit at a time, LBS first, out of the device. The MCU waits until the data is ready, clocks the external device, picks up the data in the Carry Flag (C-bitt), clears the clock line and finally accumulates the data bits in a RAM location.



ADDRESSING MODES

The MC6805U2 MCU has 10 addressing modes available for use by the programmer. They are explained briefly in the following paragraphs. For additional details and graphical illustrations, refer to the M6805 Family User Manual.

The term "effective address" (EA) is used in describing the addressing modes EA is defined as the address from which the argument for an instruction is fetched or stored

IMMEDIATE — In the immediate addressing mode, the operand is contained in the byte immediately following the opcode. The immediate addressing mode is used to access constants which do not change during program execution (e.g., a constant used to initialize a loop counter).

DIRECT — In the direct addressing mode, the effective address of the argument is contained in a single byte following the opcode byte Direct addressing allows the user to directly address the lowest 256 bytes in memory with a single 2-byte instruction. This address area includes all on-chip RAM and I/O registers and 128 bytes of ROM. Direct addressing is an effective use of both memory and time.

EXTENDED — In the extended addressing mode, the effective address of the argument is contained in the two bytes following the opcode Instructions with extended addressing mode are capable of referencing arguments anywhere in memory with a single 3-byte instruction. When using the Motorola assembler, the user need not specify whether an instruction uses direct or extended addressing. The assembler automatically selects the shortest form of the instruction.

RELATIVE — The relative addressing mode is only used in branch instructions. In relative addressing, the contents of the 8-bit signed byte following the opcode (the offset) is added to the PC if, and only if, the branch condition is true. Otherwise, control proceeds to the next instruction. The span of relative addressing is from + 129 to -126 from the opcode address. The programmer need not worry about calculating the correct offset if he uses the Motorola assembler, since it calculates the proper offset and checks to see if it is within the span of the branch.

INDEXED, NO OFFSET — In the indexed, no offset addressing mode, the effective address of the argument is contained in the 8-bit index register. Thus, this addressing mode can access the first 256 memory locations. These instructions are only one byte long. This mode is often used to move a pointer through a table or to hold the address of a frequently referenced RAM or I/O location.

INDEXED, 8-BIT OFFSET — In the indexed, 8-bit offset addressing mode, the effective address is the sum of the contents of the unsigned 8-bit index register and the unsigned byte following the opcode. This addressing mode is useful in selecting the kth element in an n element table. With this 2-byte instruction, k would typically be in X with the address of the beginning of the table in the instruction. As such tables may begin anywhere within the first 256 addressable locations and could extend as far as location 511 (41EE).

INDEXED, 16-BIT OFFSET — In the indexed, 16-bit offset addressing mode, the effective address is the sum of the contents of the unsigned 8-bit index register and the two unsigned bytes following the opcode. This addressing mode can be used in a manner similar to indexed, 8-bit offset except that this 3-byte instruction allows tables to be anywhere in memory. As with direct and extended, the Motorola assembler determines the shortest form of indexed addressing.

BIT SET/CLEAR — In the bit set/clear addressing mode, the bit to be set or cleared is part of the opcode, and the byte following the opcode specifies the direct address of the byte in which the specified bit is to be set or cleared. Thus, any read/write bit in the first 256 locations of memory, including I/O, can be selectively set or cleared with a single 2-byte instruction. See Caution under INPUT/OUTPUT paragraph.

BIT TEST AND BRANCH — The bit test and branch addressing mode is a combination of direct addressing and relative addressing. The bit which is to be tested and condition (set or clear) included in the opcode, and the address of the byte to be tested is in the single byte immediately following the opcode byte. The signed relative 8-bit offset in the

third byte is added to the PC if the specified bit is set or clear in the specified memory location. This single 3-byte instruction allows the program to branch based on the condition of any readable bit in the first 256 location of memory. The span of branching is from ± 130 to ± 125 from the opcode address. The state of the tested bit is also transferred to the Carry bit of the Condition Code. Registers. See Caution under INPUT/OUTPUT paragraph.

INHERENT — In the inherent addressing mode, all the information necessary to execute the instruction is contained in the opcode. Operations specifying only the index register or accumulator, as well as control instructions with no other arguments, are included in this mode. These instructions are one byte long.

INSTRUCTION SET

The MC6805U2 MCU has a set of 59 basic instructions, which when combined with the 10 addressing modes produce 207 usable opcodes. They can be divided into five different types register/memory, read/modify/write, branch, bit manipulation, and control. The following paragraphs briefly explain each type. All the instructions within a given type are presented in individual tables.

REGISTER/MEMORY INSTRUCTIONS — Most of these instructions use two operands. One operand is either the accumulator or the index register. The other operand is obtain-

ed from memory using one of the addressing modes. The jump unconditional (JMP) and jump to subroutine (JSR) instructions have no register operand. Refer to Table 2.

READ/MODIFY/WRITE INSTRUCTIONS — These instructions read a memory location or a register, modify or test its contents, and write the modified value back to memory or to the register; see Caution under INPUT/OUT-PUT paragraph The test for negative or zero (TST) instruction is included in the read/modify/write instruction though it does not perform the write Refer to Table 3

BRANCH INSTRUCTIONS — The branch instructions cause a branch from the program when a certain condition is met. Refer to Table 4

BIT MANIPULATION INSTRUCTIONS — The instructions are used on any bit in the first 256 bytes of the memory, see Caution under INPUT/OUTPUT paragraph One group either sets or clears The other group performs the bit test and branch operations Refer to Table 5

CONTROL INSTRUCTION – The control instructions control the MCU operations during program execution Refer to Table 6

ALPHABETICAL LISTING — The complete instruction set is given in alphabetical order in Table 7

 $\ensuremath{\mathsf{OPCODE}}\xspace$ $\ensuremath{\mathsf{MAP}}\xspace -$ Table 8 is an opcode map for the instruction used on the MCU

TABLE 2 - REGISTER/MEMORY INSTRUCTIONS

| | | | | | | | | | Α | ddressin | g Mod | es | | | | | | | |
|---|----------|------------|------------|-------------|------------|------------|-------------|------------|------------|-------------|------------|-----------------|-------------|------------|------------|-------------|------------|------------------|-------------|
| | | | Immed | ıate | | Direc | et | | Extend | ed | (| Index No Off | | (8 | Index | | (10 | Index 6 Bit C | |
| Function | Mnemonic | Op Code | # Bytes | # Cycles | Op Code | # Bytes | # Cycles | Op Code | # Bytes | # Cycles | Op Code | # Bytes | # Cycles | Op Code | # Bytes | # Cycles | OP Code | # Bytes | # Cycles |
| Load A from Memory | LDA | A6 | 2 | 2 | 86 | 2 | 4 | С6 | 3 | 5 | F6 | 1 | 4 | E6 | 2 | 5 | D6 | 3 | 6 |
| Load X from Memory | LDX | AE | 2 | 2 | BE | 2 | 4 | CE | 3 | 5 | FE | 1 | 4 | EE | 2 | 5 | DE | 3 | 6 |
| Store A in Memory | STA | _ | - | | B7 | 2 | 5 | C7 | 3 | 6 | F7 | 1 | 5 | E 7 | 2 | 6 | D7 | 3 | 7 |
| Store X in Memory | STX | - | - | | BF | 2 | 5 | CF | 3 | 6 | FF | 1 | 5 | EF | 2 | 6 | DF | 3 | 7 |
| Add Memory to A | ADD | AB | 2 | 2 | ВВ | 2 | 4 | СВ | 3 | 5 | FB | 1 | 4 | EB | 2 | 5 | DB | 3 | 6 |
| Add Memory and Carry to A | ADC | Α9 | 2 | 2 | В9 | 2 | 4 | С9 | 3 | 5 | F9 | 1 | 4 | E9 | 2 | 5 | D9 | 3 | 6 |
| Subtract Memory | SUB | A0 | 2 | 2 | В0 | 2 | 4 | CO | 3 | 5 | FO | 1 | 4 | EO | 2 | 5 | DO | 3 | 6 |
| Subtract Memory from A with Borrow | SBC | A2 | 2 | 2 | B2 | 2 | 4 | C2 | 3 | 5 | F2 | 1 | 4 | E2 | 2 | 5 | D2 | 3 | 6 |
| AND Memory to A | AND | Α4 | 2 | 2 | 84 | 2 | 4 | C4 | 3 | 5 | F4 | 1 | 4 | E4 | 2 | 5 | D4 | 3 | 6 |
| OR Memory with A | ORA | AA | 2 | 2 | BA | 2 | 4 | CA | 3 | 5 | FA | 1 | 4 | EA | 2 | 5 | DA | 3 | 6 |
| Exclusive OR Memory with A | EOR | A8 | 2 | 2 | В8 | 2 | 4 | С8 | 3 | 5 | F8 | 1 | 4 | E8 | 2 | 5 | D8 | 3 | 6 |
| Arithmetic Compare A with Memory | · CMP | Α1 | 2 | 2 | В1 | 2 | 4 | C1 | 3 | 5 | F1 | 1 | 4 | E1 | 2 | 5 | D1 | 3 | 6 |
| Arithmetic Compare X with Memory | СРХ | А3 | 2 | 2 | В3 | 2 | 4 | С3 | 3 | 5 | F3 | 1 | 4 | E3 | 2 | 5 | D3 | 3 | 6 |
| Bit Test Memory with A (Logical Compare) | ВІТ | A 5 | 2 | 2 | В5 | 2 | 4 | C5 | 3 | 5 | F5 | 1 | 4 | E5 | 2 | 5 | D5 | 3 | 6 |
| Jump Unconditional | JMP | - | | | BC | 2 | 3 | CC | 3 | 4 | FC | 1 | 3 | EC | 2 | 4 | DC | 3 | 5 |
| Jump to Subroutine | JSR | - | - | | BD | 2 | 7 | CD | 3 | 8 | FD | 1 | 7 | ED | 2 | 8 | DD | 3 | 9 |

TABLE 3 - READ/MODIFY/WRITE INSTRUCTIONS

| | | | | | | | | Addr | essing | Modes | | | | | | |
|------------------------------|----------|------------|------------|-------------|------------|------------|-------------|------------|------------|-------------|------------|------------|-------------|------------|----------------|-------------|
| | | 1 | nheren | t (A) | i | nheren | t (X) | | Dire | ct | (| Index | | (8 | Index Bit O | |
| Function | Mnemonic | Op Code | # Bytes | # Cycles | Op Code | # Bytes | # Cycles | Op Code | # Bytes | # Cycles | Op Code | # Bytes | # Cycles | Op Code | # Bytes | # Cycles |
| Increment | INC | 4C | 1 | -4 | 5C | 1 | 4 | 3C | 2 | 6 | 7C | 1 | 6 | 6C | 2 | 7 |
| Decrement | DEC | ·4A | 1 | 4 | 5A | 1 | 4 | 3A | 2 | 6 | 7A | 1 | 6 | 6A | 2 | 7 |
| Clear | CLR | 4F | 1 | 4 | 5F | 1 | 4 | 3F | 2 | 6 | 7F | 1 | 6 | 6F | 2 | 7 |
| Complement | сом | 43 | 1 | 4 | 53 | 1 | 4 | 33 | 2 | 6 | 73 | 1 | 6 | 63 | 2 | 7 |
| Negate (2 s Complement) | NEG | 40 | 1 | 4 | 50 | 1 | 4 | 30 | 2 | 6 | 70 | 1 | 6 | 60 | 2 | 7 |
| Rotate Left Thru Carry | ROL | 49 | 1 | 4 | 59 | 1 | 4 | 39 | 2 | 6 | 79 | 1 | 6 | 69 | 2 | 7 |
| Rotate Right Thru Carry | ROR | 46 | 1 | 4 | 56 | 1 | 4 | 36 | 2 | 6 | 76 | 1 | 6 | 66 | 2 | 7 |
| Logical Shift Left | LSL | 48 | 1 | 4 | 58 | 1 | 4 | 38 | 2 | 6 | 78 | 1 | 6 | 68 | 2 | 7 |
| Logical Shift Right | LSR | 44 | 1 | 4 | 54 | 1 | 4 | 34 | 2 | 6 | 74 | 1 | 6 | 64 | 2 | 7 |
| Arithmetic Shift Right | ASR | 47 | 1 | 4 | 57 | 1 | 4 | 37 | 2 | 6 | 77 | 1 | 6 | 67 | 2 | 7 |
| Test for Negative or Zero | TST | 4D | 1 | 4 | 5D | 1 | 4 | 3D | 2 | 6 | 7D | 1 | 6 | 6D | 2 | 7 |

TABLE 4 - BRANCH INSTRUCTIONS

| | | Relative | Address | ing Mode |
|--|----------|----------|---------|----------|
| | | Op | # | # |
| Function | Mnemonic | Code | Bytes | Cycles |
| Branch Always | BRA | 20 | 2 | 4 |
| Branch Never | BRN | 21 | 2 | 4 |
| Branch IFF Higher | ВНІ | 22 | 2 | 4 |
| Branch (FFLower or Same | BLS | 23 | 2 | 4 |
| Branch IFF Carry Clear | BCC | 24 | 2 | 4 |
| (BranchIFFHigher or Same) | (BHS) | 24 | 2 | 4 |
| Branch IFF Carry Set | BCS | 25 | 2 | 4 |
| (Branch IFF Lower) | (BLO) | 25 | 2 | 4 |
| Branch IFF Not Equal | BNE | 26 | 2 | 4 |
| Branch IFF Equal | BEQ | 27 | 2 | 4 |
| Branch IFF Half Carry Clear | внсс | 28 | 2 | 4 |
| Branch IFF Half Carry Set | BHCS | 29 | 2 | 4 |
| BranchIFF Plus | BPL | 2A | 2 | 4 |
| BranchIFF Minus | ВМІ | 2B | 2 | 4 |
| Branch IFF Interupt Mask Bit is Clear | ВМС | 2C | 2 | 4 |
| BranchIFFInterrupt Mask Bit is Set | BMS | 2D | 2 | 4 |
| Branch IFF Interrupt Line is Low | BIL | 2E | 2 | 4 |
| Branch IFF Interrupt Line is High | він | 2F | 2 | 4 |
| Branch to Subroutine | BSR | AD | 2 | 8 |

TABLE 5 — BIT MANIPULATION INSTRUCTIONS

| | | | | Addres | sing Mode | 5 | |
|---------------------------|-------------------|------------|--------|--------|------------|----------|--------|
| | | Bit | Set/Cl | ear | Bit Te | st and E | Branch |
| | | Op | # | # | Op | # | Ħ |
| Function | Mnemonic | Code | Bytes | Cycles | Code | Bytes | Cycles |
| Branch IFF Bit n is set | BRSET n (n = 0 7) | | - | _ | 2 • n | 3 | 10 |
| Branch IFF Bit n is clear | BRCLR n (n = 0 7) | _ | - | _ | 01 + 2 • n | 3 | 10 |
| Set Bit n | BSET n (n = 0 7) | 10 + 2 • n | 2 | 7 | | | _ |
| Clear bit n | BCLR n (n = 0 7) | 11 + 2 • n | 2 | 7 | _ | _ | _ |

TABLE 6 - CONTROL INSTRUCTIONS

| | | | Inherent | |
|--------------------------|----------|------|----------|--------|
| | | Op | # | # |
| Function | Mnemonic | Code | Bytes | Cycles |
| Transfer A to X | TAX | 97 | 1 | 2 |
| Transfer X to A | TXA | 9F | 1 | 2 |
| Set Carry Bit | SEC | 99 | 1 | 2 |
| Clear Carry Bit | CLC | 98 | 1 | 2 |
| Set Interrupt Mask Bit | SEI | 9B | 1 | 2 |
| Clear Interrupt Mask Bit | CLI | 9A | 1 | 2 |
| Software Interrupt | SWI | 83 | 1 | 11 |
| Return from Subroutine | RTS | 81 | 1 | 6 |
| Return from Interrupt | RTI · | 80 | 1 | 9 |
| Reset Stack Pointer | RSP | 9C | 1 | 2 |
| No-Operation | NOP | 9D | 1 | 2 |

TABLE 7 - INSTRUCTION SET

| | | | | A | ddressing | Modes | | | | | Co | ond | itio | n C | ode |
|----------|----------|-----------|--------|--|--|-------------|--------------|--|----------|--|----|-----|--------------|-----|----------|
| | <u> </u> | | | | | | | 1 | Bit | Bit | | Γ | | | |
| | i | | | | | Indexed | | Indexed | | Test & | | 1 | | 1 | 1 |
| Mnemonic | Inherent | Immediate | Direct | Extended | Relative | (No Offset) | (8 Bits) | (16 Bits) | Clear | Branch | Н | ı | Ν | Z | С |
| ADC | | Х | X | Х | | × | X | Х | | | ٨ | • | ^ | ٨ | ٨ |
| ADD | | x | X | X | | × | X | Х | | | ^ | • | ^ | ٨ | ٨ |
| AND | | X | Х | X | | × | X | X | | | • | • | ٨ | ٨ | • |
| ASL | X | | X | | | X | Х | | | | • | • | ^ | ٨ | ٨ |
| ASR | X | | Х | | | X | X | | | | • | • | ٨ | ٨ | ^ |
| BCC | i | | | | X | | | | | | • | • | • | • | • |
| BCLR | l | | | | <u> </u> | | | | X | | • | • | • | • | • |
| BCS | | | | | X | | | | | | • | • | • | • | • |
| BEQ | | | | | X | | ļ | | | | • | • | • | • | • |
| ВНСС | | | | | × | | | | | <u> </u> | • | • | • | • | • |
| BHCS | | | | | X | | | | | - | • | • | • | • | • |
| BHI | | | | | × | | | | | | • | • | • | • | • |
| BHS | | | | | X | | | | <u> </u> | | • | • | • | • | • |
| BIH | | | | | X | | | | | | • | - | • | • | • |
| BIL | | | | | × | | | | L | | | ₩ | - | - | - |
| BIT | | x | X | × | ^ | X | X | | ļ | | • | • | • | • | • |
| | | | | ^ - | X | | <u> </u> | × | <u> </u> | | • | • | ^ | ^ | • |
| BLO | | | | ļ | | | | | <u> </u> | ļ | • | • | • | • | • |
| BLS | | | | | X | | | | | | • | • | • | • | • |
| вмс | | | | | X | | | | | | • | • | • | • | • |
| BMI | | | | | | | | | | | • | • | • | • | • |
| BMS | | | | | | | | <u> </u> | | | • | • | • | • | • |
| BNE | | | | | | | | | | | • | • | • | • | • |
| BPL | | | | | | | | | | | • | • | • | • | • |
| BRA | | | | | | | | | | | • | • | • | • | • |
| BRN | | | | | | | | | | | • | • | • | • | • |
| BRCLR | | | | | | | | | | X | • | • | • | • | ٨ |
| BRSET | | | | | | | | | | X | • | • | • | • | ٨ |
| BSET | | | | | | | | | X | | • | • | • | • | • |
| BSR | | | | | X | | | | | | • | • | • | • | • |
| CLL | Х | | | | | | | | | <u> </u> | • | • | • | • | 0 |
| CLI | Х | | | | | | | | | | • | 0 | • | • | • |
| CLR | X | | Х | | | Х | X | | | | • | • | 0 | 1 | • |
| CMP | | х | X | × | | X | X | × | | | • | • | 7 | ^ | ^ |
| COM | Х | · · · | X | <u> </u> | | X | × | - ^ - | | | • | • | \ | ^ | 1 |
| CPX | <u> </u> | x | × | × | | × | × | × | <u> </u> | | • | - | ^ | ^ | <u>,</u> |
| DEC | × | | × | ^ | | × | - x | <u> </u> | <u> </u> | ļ | • | • | <u> </u> | ^ | • |
| EOR | | x | × | × | | × | X | × | ļ | | • | _ | _ | | |
| | | | X | | | | | _^_ | ļ | | - | • | ^ | ^ | • |
| INC | X | | | | | X | X | | | | • | • | _ | ^ | • |
| JMP | | | X | X | | Х | X | X | | | • | • | • | • | • |
| JSR | | | X | X | | X | X | Х | | | • | • | • | • | • |
| LDA | | X | X | X | | Х | X | Х | L | | • | • | ^ | ^ | • |
| LDX | | X | Х | Х | | Х | X | X | | | • | • | ^ | ^ | • |
| LSL | Х | | Х | | | Х | Х | | | | • | • | ^ | ^ | ^ |
| LSR | Х | | Х | | | Х | Х | | | | • | • | 0 | ^ | ^ |
| NEQ | Х | | Х | | | Х | X | | | | • | • | ٨ | ^ | ^ |
| NOP | Х | | | | | | | | | | • | • | • | • | • |
| ORA | | Х | Х | Х | | Х | X | Х | | | • | • | ٨ | ^ | • |
| ROL | Х | | X | 1 | | Х | × | | | | • | • | ٨ | ٨ | ^ |
| RSP | X | | | | | | | | | | • | • | • | • | • |

Condition Code Symbols

- H Half Carry (From Bit 3)
- I Interrupt Mask
 N Negative (Sign Bit)
 Z Zero

- C Carry/Borrow
 Λ Test and Set if True, Cleared Otherwise
- Not Affected

TABLE 7 - INSTRUCTION SET (CONTINUED)

| | | | | A | ddressing | Modes | | | | Co | nd | itio | n C | ode |
|----------|----------|-----------|--------|----------|-----------|------------------------|----------|----------------------|-------------------------|----|----|------|-----|-----|
| Mnemonic | Inherent | Immediate | Direct | Extended | Relative | Indexed (No Offset) | | Indexed (16 Bits) | Bit Test & Branch | H | - | Z | z | С |
| RTI | X | | | | | | 1 | | | ? | ? | ? | ? | ? |
| RTS | х | | | | | | | | | • | • | • | • | • |
| SBC | | × | Х | X | | × | X | X | | • | • | ٨ | ٨ | ٨ |
| SEC | X | | | | | | <u> </u> | | | • | • | • | • | 1 |
| SEI | Х | | | | i | <u> </u> | † | · | | • | 1 | • | • | • |
| STA | | | X | X | | X | × | X | | • | • | ٨ | ٨ | • |
| STX | | | X | X | | × | X | Х | | • | • | ٨ | ٨ | • |
| SUB | | × | Х | Х | | X | X | X | | • | • | Λ | ٨ | ^ |
| SWI | Х | | | | | | | | | • | 1 | • | • | • |
| TAX | × | | | | | | İ | ļ | | • | • | • | • | • |
| TST | × | | X | | | X | X | | | • | • | ٨ | ٨ | • |
| TXA | X | | | | | | | | | • | • | • | • | • |

Condition Code Symbols

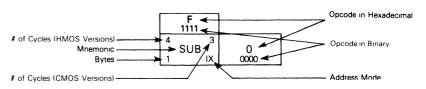
TABLE 8 - M6805 FAMILY OPCODE MAP

| | Bit Mar | nipulation | Branch | | Re | ad/Modify/\ | Vrite | | Cor | ntrol | | | Registe | r/Memory | | | |
|-----------|-------------------------|-----------------------|----------------------|---------------------|----------------------|----------------------|---------------------|--------------------|--------------------|---------------------|---------------------|---------------------|---------------------|---------------------|---------------------|--------------------|-----------|
| | BTB | BSC | REL | DIR | INH(A) | INH(X) | IX1 | I <u>X</u> | INH | INH | IMM | DIR | EXT | IX2 | IX1 | IX F | 1 |
| Low | 0000 | 0001 | 0010 | 3 0011 | 0100 | 5 0101 | 6 0110 | 0111 | 8 1000 | 9 1001 | A 1010 | B 1011 | 1100 | D 1101 | E 1110 | 1111 | Hi |
| 0000 | BRSETO 3 BTB | BSET0 2 BSC | BRA 2 REL | 6 5 NEG 2 DIR | 4 NEGA 1 INH | 4 NEGX 1 INH | 7 NEG 2 IX1 | 6 NEG 5 | RTI 1 INH | | SUB 2 IMM | SUB DIR | SUB SUB | 6 SUB 3 | SUB 2 IX1 | SUB 1 | 0000 |
| 0001 | BRCLRO BRELRO | BCLR0 BSC | BRN 2 REL | | | | | | 6 RTS 1 INH | | CMP 2 IMM | CMP DIR | CMP 3 EXT | CMP 3 IX2 | 5 CMP 2 IX1 | CMP IX | 1 0001 |
| 2 0010 | 10 5 BRSET1 3 BTB | BSET1 5 2 BSC 5 | 4 BHI 2 REL | 6 5 | | 4 3 | 7 6 | 6 5 | 11 10 | | SBC 2 IMM | SBC DIR | SBC SBC SEXT | SBC 3 IX2 | 5 SBC 2 IX1 | SBC IX | 2 0010 |
| 3 0011 | BRCLR1 3 BTB | BCLR1 2 BSC | BLS 2 REL | COM 2 DIR 5 | COMA 1 INH 4 3 | COMX 1 INH | COM 2 IX1 | COM 1X | SWI 1 INH | | CPX 2 IMM | CPX 2 DIR 3 | CPX 3 EXT | CPX 3 IX2 | CPX 2 IX1 | CPX 1 IX 4 3 | 3 0011 |
| 4 0100 | BRSET2 3 BTB | BSET2 2 BSC | BCC REL | LSR 2 DIR | LSRA 1 INH | LSRX 1 INH | LSR 2 IX1 | LSR | | | AND 2 | AND DIR | AND 3 EXT | AND 3 IX2 | AND IX1 | AND IX | 0100 |
| 5 0101 | BRCLR2 3 BTB | BCLR2 2 BSC | BCS 2 REL | 6 5 | 4 3 | 4 3 | 7 6 | 6 5 | | | BIT 2 1MM 2 | BIT 2 DIR | BIT 3 EXT | BIT 3 IX2 | BIT 2 IX1 | BIT IX | 5 0101 |
| 6 0110 | BRSET3 3 BTB | BSET3 2 BSC 7 5 | BNE 2 REL | ROR 2 DIR 6 5 | RORA 1 INH | RORX 1 INH 4 3 | ROR 2 X1 | ROR | | 2 2 | LDA 2 IMM | LDA 2 DIR 5 4 | LDA 3 EXT | LDA 3 IX2 | LDA 2 ix1 6 5 | LDA 1 IX 5 4 | 6 0110 |
| 7 0111 | BRCLR3 3 BTB | BCLR3 2 BSC 7 5 | BEQ 2 REL 4 3 | ASR 2 DIR | ASRA 1 INH 4 3 | ASRX 1 INH 4 3 | ASR 2 X1 7 6 | ASR 1 IX | | TAX 1 INH 2 2 | 2 2 | STA DIR | STA 3 EXT | STA 3 IX2 6 5 | STA 2 IX1 5 4 | STA 1 1X 4 3 | 7 0111 |
| 1000 | BRSET4 3 BTB 10 5 | BSET4 2 BSC 7 5 | BHCC 2 REL 4 3 | LSL 2 DIR 6 5 | LSLA 1 INH 4 3 | LSLX 1 INH 4 3 | LSL 2 IX1 7 6 | LSL 1 IX 6 5 | | CLC 1 INH 2 2 | EOR 2 IMM 2 | EOR 2 DIR 4 3 | EOR 3 EXT 5 4 | EOR 3 IX2 6 5 | EOR 2 1X1 5 4 | EOR 1 X 3 | 1000 |
| 9 1001 | BRCLR4 3 BTB 10 5 | BCLR4 2 BSC 7 5 | | ROL 2 DIR 6 5 | ROLA 1 INH 4 3 | ROLX 1 INH 4 3 | ROL 2 IX1 7 6 | ROL 1 IX 6 5 | | SEC 1 INH 2 2 | ADC 2 IMM 2 2 | ADC 2 DIR 4 3 | | | | ADC 1 IX 4 3 | 9 1001 |
| A 1010 | BRSET5 3 BTB 10 5 | BSET5 2 BSC 7 5 | BPL 2 REL 4 3 | DEC 2 DIR | DECA 1 INH | DECX 1 INH | DEC 1X1 | DEC IX | | CLI 1 INH 2 2 | ORA 2 IMM 2 2 | 4 3 | | ORA 3 IX2 6 5 | ORA 2 IX1 5 4 | ORA 1 IX 4 3 | A 1010 |
| B 1011 | BRCLR5 3 BTB 10 5 | BCLR5 2 BSC 7 5 | | 6 5 | 4 3 | 4 3 | 7 6 | 6 5 | | SEI 1 INH 2 2 | ADD 2 IMM | ADD DIR | ADD 3 EXT 4 3 | ADD 3 IX2 5 4 | ADD 2 IX1 4 3 | ADD 1X 3 2 | B 1011 |
| C 1100 | BRSET6 3 BTB 10 5 | BSET6 2 BSC 7 5 | | INC 2 DIR 6 4 | INCA 1 INH 4 3 | INCX 1 INH 4 3 | INC 2 IX1 7 5 | 1 INC 1 IX | | RSP 1 INH 2 2 | | JMP 2 DIR 7 5 | JMP 3 EXT 8 6 | | JMP 2 IX1 8 6 | JMP 1 IX 7 5 | C 1100 |
| D 1101 | BRCLR6 3 BTB 10 5 | | BMS 2 REL 4 3 | TST 2 DIR | TSTA 1 INH | TSTX 1 INH | TST 2 IX1 | TST IX | 2 | NOP 1 INH | BSR 2 REL 2 2 | JSR 2 DIR 4 3 | JSR 3 EXT 5 4 | JSR 3 1X2 6 5 | JSR 2 1X1 5 4 | JSR 1 IX 4 3 | D 1101 |
| E 1110 | BRSET7 3 BTB 10 5 | | BIL 2 REL 4 3 | 6 5 | 4 3 | 4 3 | 7 6 | 6 5 | STOP 1 INH 2 | 2 2 | LDX 2 IMM | LDX 2 DIR 5 4 | LDX 3 EXT 6 5 | LDX 3 IX2 7 6 | | 1 IX 5 4 | E 1110 |
| F 1111 | BRCLR7 3 BTB | BCLR7 2 BSC | BIH 2 REL | CLR 2 DIR | CLRA 1 INH | CLRX 1 INH | CLR 2 IX1 | CLR 1 IX | WAIT 1 INH | TXA 1 INH | | STX 2 DIR | STX 3 EXT | STX 3 IX2 | STX 2 IX1 | STX 1 IX | F 1111 |

Abbreviations for Address Modes

INH Inherent IMM Immediate DIR Direct EXT Extended REL Relative BSC Bit Set/Clear BTB Bit Test and Branch IX Indexed (No Offset) IX1 Indexed, 1 Byte (8-Bit) Offset Indexed, 2 Byte (16-Bit) Offset CMOS Versions Only IX2

LEGEND

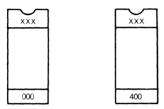


ORDERING INFORMATION

The information required when ordering a custom MCU is listed below. The ROM program may be transmitted to Motorola on EPROM(s) or an MDOS disk file.

To initiate a ROM pattern for the MCU it is necessary to first contact you local Motorola representative or Motorola distributor

EPROMs — The MCM2716 or MCM2532 type EPROMs, programmed with the customer program (positive logic sense for address and data), may be submitted for pattern generation. The EPROM must be clearly marked to indicate which EPROM corresponds to which address space. The recommended marking procedure is illustrated below.



XXX = Customer ID

After the EPROM(s) are marked they should be placed in conductive IC carriers and securely packed. Do not use styrofoam

VERIFICATION MEDIA

All original pattern media (EPROMs or Floppy Disk) are filed for contractual purposes and are not returned. A computer listing of the ROM code will be generated and returned along with a listing verification form. The listing should be

thoroughly checked and the verification form completed, signed, and returned to Motorola. The signed verification form constitutes the contractual agreement for creation of the customer mask. If desired, Motorola will program one blank EPROM from the data file used to create the custom mask to aid in the verification process.

ROM VERIFICATION UNITS (RVUs)

Ten MCUs containing the customer's ROM pattern will be sent for program verification. These units will have been made using the custom mask but are for the purpose of ROM verification only. For expediency they are usually unmarked, packaged in ceramic, and tested only at room temperature and 5 volts. These RVUs are included in the mask charge and are not production parts. The RVUs are thus not guaranteed by Motorola Quality Assurance, and should be discarded after verification is completed.

FLEXIBLE DISKS

The disk media submitted must be single-sided, single-density, 8-inch, MDOS compatible floppies. The customer must write the binary file name and company name on the disk with a felt-tip pen. The minimum MDOS system files as well as the absolute binary object file (filename. LO type of file) from the M6805 cross assembler must be on the disk. An object file made from a memory dump using the ROLLOUT command is also acceptable. Consider submitting a source listing as well as the following files filename. LX (EXORciser® loadable format) and filename. SA (ASCII Source Code). These files will of course be kept confidential and are used 1) to speed up the process in-house if any problems arise, and 2) to speed up the user-to-factory interface if the user finds any software errors and needs assistance quickly from Motorola factory representatives.

MDOS is Motorola's Disk Operating System available on development systems such as EXORcisers, EXORsets, etc

4

MC6805U2 MCU ORDERING INFORMATION

| Date | Customer PO Nu | |
|---|---------------------------------|--|
| Customer Company | | |
| Address | | MC |
| City | State | Zıp |
| Country | | |
| Phone | Extension | |
| Customer Contact Person | | |
| Customer Part Number | | |
| OPTION LIST | | |
| 1 | ons for your MCU from the fol | lowing list A |
| | ask will be generated from this | |
| Timer Clock Source | | |
| □ Internal □ In | | İ |
| ☐ TIMER input pin | | |
| | | |
| Timer Prescaler | | |
| ☐ 2º (divide by 1) | | 24 (divide by 16) |
| ☐ 2¹ (divide by 2) ☐ 2² (divide by 4) | | 2⁵ (divide by 32) 2⁶ (divide by 64) |
| ☐ 2³ (divide by 8) | | ☐ 2' (divide by 128) |
| | | |
| Internal Oscillator Input | Port A | A Output Drive |
| ☐ Crystal | | ☐ CMOS and TTL |
| ☐ Resistor | | ☐ TTL Only |
| | | |
| Low Voltage Inhibit □ Disable | | |
| □ Enable | | |
| | | |
| Pattern Media (All other media requir | | |
| ☐ EPROMs (MCM27 | 716 or MCM2532 | ☐ Floppy Disk |
| | | ☐ Other |
| Clock Freq | | |
| Temp Range | | d) □ −40° to +85°C* □ −40° to |
| *Requires prior factory approval | | 10 10 100 0 |
| Marking Information (12 Characters Maximu | m) | |
| marking information (12 Characters Maximu | ш | |
| | | |
| | | |



MC6809 (1.0 MHz) MC68A09 (1.5 MHz) MC68B09

8-BIT MICROPROCESSING UNIT

The MC6809 is a revolutionary high-performance 8-bit microprocessor which supports modern programming techniques such as position independence, reentrancy, and modular programming

This third-generation addition to the M6800 family has major architectural improvements which include additional registers, instructions, and addressing

The basic instructions of any computer are greatly enhanced by the presence of powerful addressing modes. The MC6809 has the most complete set of addressing modes available on any 8-bit microprocessor today

The MC6809 has hardware and software features which make it an ideal processor for higher level language execution or standard controller applications

MC6800 COMPATIBLE

- Hardware Interfaces with All M6800 Peripherals
- Software Upward Source Code Compatible Instruction Set and Addressing Modes

ARCHITECTURAL FEATURES

- Two 16-bit Index Registers
- Two 16-bit Indexable Stack Pointers
- Two 8-bit Accumulators can be Concatenated to Form One 16-Bit Accumulator
- Direct Page Register Allows Direct Addressing Throughout Memory

HARDWARE FEATURES

- On-Chip Oscillator (Crystal Frequency = 4XE)
- DMA/BREQ Allows DMA Operation on Memory Refresh
- Fast Interrupt Request Input Stacks Only Condition Code Register and Program Counter
- MRDY Input Extends Data Access Times for Use with Slow Memory Interrupt Acknowledge Output Allows Vectoring By Devices
- SYNC Acknowledge Output Allows for Synchronization to External Event
- Single Bus-Cycle RESET
- Single 5-Volt Supply Operation
 NMI Inhibited After RESET Until After First Load of Stack Pointer
- Early Address Valid Allows Use With Slower Memories
- Early Write-Data for Dynamic Memories

SOFTWARE FEATURES

- 10 Addressing Modes
 - 6800 Upward Compatible Addressing Modes
- Direct Addressing Anywhere in Memory Map
- Long Relative Branches
- Program Counter Relative
- True Indirect Addressing
- Expanded Indexed Addressing
 - 0-, 5-, 8-, or 16-bit Constant Offsets
 - 8-, or 16-bit Accumulator Offsets
- Auto-Increment/Decrement by 1 or 2
- Improved Stack Manipulation
- 1464 Instructions with Unique Addressing Modes
- 8 × 8 Unsigned Multiply
- 16-bit Arithmetic
- Transfer/Exchange All Registers
- Push/Pull Any Registers or Any Set of Registers
- Load Effective Address

HMOS

(2.0 MHz)

(HIGH DENSITY N-CHANNEL, SILICON-GATE)

8-BIT MICROPROCESSING UNIT

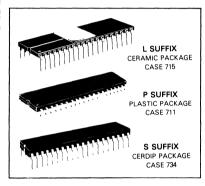


FIGURE 1 - PIN ASSIGNMENT V_{SS}**I**1 40 HALT 39 XTAL NMI I TRQ 13 38 LEXTAL FIRO 4 37 DRESET BS □ 5 36 MRDY ВА**Д**6 35 **1** Q 34 **1** E VCC 7 33 DMA/BREQ A0**[**8 32 h R/W A1 1 9 A2 d 10 31 DO A3 **1**11 30 DD1 29 D2 A4 1 12 28 **h**D3 A5**∏**13 27 DD4 A6 14 26 D5 A7 115 A8 d 16 25 D6 A9 17 24 D7 23 A 15 A10**1**118 A11**1**19 22 A14 A12 1 20 21 hA13

MAXIMUM RATINGS

| Rating | Symbol | Value | Unit |
|--|------------------|--|------|
| Supply Voltage | Vcc | -03 to +70 | ٧ |
| Input Voltage | V _{in} | -03 to +70 | ٧ |
| Operating Temperature Range MC6809, MC68A09, MC68B09 MC6809C, MC68A09C, MC68B09C | ТА | T _L to T _H 0 to +70 -40 to +85 | °C |
| Storage Temperature Range | T _{stg} | - 55 to + 150 | °C |

THERMAL CHARACTERISTICS

| Characteristic | Symbol | Value | Unit |
|--------------------|-------------|-------|-------|
| Thermal Resistance | | | |
| Ceramic | | 50 | °c/w |
| Cerdip | θ JA | 60 | J*C/W |
| Plastic | | 100 | |

This device contains circuitry to protect the inputs against damage due to high static voltages or electric fields, however, it is advised that normal precautions be taken to avoid application of any voltage higher than maximum rated voltages to this high impedance circuit Reliability of operation is enhanced if unused inputs are tied to an appropriate logic voltage levels (e.g., either VSS or VCC)

POWER CONSIDERATIONS

The average chip-junction temperature, T.J., in °C can be obtained from

$$T_{J} = T_{A} + (P_{D} \bullet \theta_{J} A)$$
Where

T_A ≡ Ambient Temperature, °C

θ J A ≡ Package Thermal Resistance, Junction-to-Ambient, °C/W

PD = PINT + PPORT

PINT = ICC × VCC, Watts - Chip Internal Power

PPORT = Port Power Dissipation, Watts - User Determined

For most applications PPORT ≪PINT and can be neglected PPORT may become significant if the device is configured to drive Darlington bases or sink LED loads.

An approximate relationship between PD and TJ (if PPORT is neglected) is

Solving equations 1 and 2 for K gives

$$K = P_D \bullet (T_A + 273 \circ C) + \theta_{JA} \bullet P_D^2$$

(3)

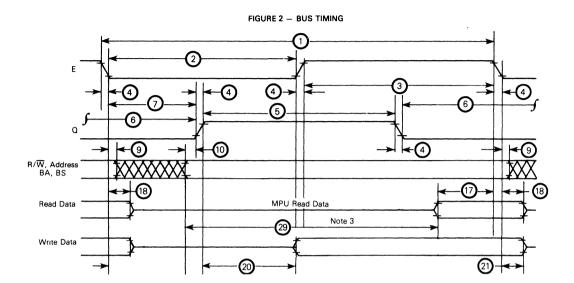
(2)

Where K is a constant pertaining to the particular part. K can be determined from equation 3 by measuring PD (at equilibrium) for a known TA. Using this value of K the values of PD and TJ can be obtained by solving equations (1) and (2) iteratively for any value of TA.

ELECTRICAL CHARACTERISTICS ($V_{CC} = 5.0 \text{ V} \pm 5\%$, $V_{SS} = 0$, $T_A = 0$ to 70°C unless otherwise noted)

| Characterist | ic | Symbol | Min | Тур | Max | Unit |
|--|--|-------------------------------------|---|-------------|---------------------|------|
| Input High Voltage | Logic, EXTAL RESET | V _{IH} V _{IHR} | V _{SS} +20 V _{SS} +40 | - | V _{CC} | ٧ |
| Input Low Voltage | Logic, EXTAL, RESET | VIL | V _{SS} -03 | - | V _{SS} +08 | V |
| Input Leakage Current (V _{In} = 0 to 5 25 V, V _{CC} = max) | Logic | l _{in} | - | - | 2 5 | μΑ |
| DC Output High Voltage (ILoad = - 205 µA, VCC = min) (ILoad = - 145 µA, VCC = min) (ILoad = - 100 µA, VCC = min) | D0-D7 A0-A15, R/W, Q, E BA, BS | Voн | V _{SS} +24 V _{SS} +24 V _{SS} +24 | - - - | _ _ _ | V |
| DC Output Low Voltage (I _{Load} = 2 0 mA, V _{CC} = min) | | VOL | - | - | V _{SS} +05 | V |
| Internal Power Dissipation (measured at TA = 0° | C in steady state operation) | PINT | _ | - | 10 | W |
| Capacitance # $(V_{In} = 0, T_A = 25$ °C, f = 1 0 MHz) | D0-D7, RESET Logic Inputs, EXTAL, XTAL | C _{in} | - | 10 10 | 15 15 | pF |
| | A0-A15, R/W, BA, BS | C _{out} | | | 15 | pF |
| Frequency of Operation (Crystal or External Input) | MC6809 MC68A09 MC68B09 | fXTAL | 0 4 0 4 0 4 | - - | 4 6 8 | MHz |
| Three-State (Off State) Input Current (V _{In} = 0 4 to 2 4 V, V _{CC} = max) | D0-D7 A0-A15, R/W | ITSI | _ | 20 | 10 100 | μΑ |

[#] capacitances are periodically tested rather than 100% tested



BUS TIMING CHARACTERISTICS (See Notes 1 and 2)

| ldent. | Characteristics S | | MC6809 | | MC68A09 | | MC68B09 | | Unit |
|--------|---|---------------------|--------|-------|---------|-------|---------|-------|------|
| Number | | | Min | Max | Min | Max | Min | Max | Oint |
| 1 | Cycle Time (See Note 5) | t _{cyc} | 10 | 10 | 0 667 | 10 | 05 | 10 | μS |
| 2 | Pulse Width, E Low | PW _{EL} | 430 | 5000 | 280 | 5000 | 210 | 5000 | ns |
| 3 | Pulse Width, E High | PWEH | 450 | 15500 | 280 | 15700 | 220 | 15700 | ns |
| 4 | Clock Rise and Fall Time | t _r , tf | - | 25 | - | 25 | - | 20 | ns |
| 5 | Pulse Width, Q High | PWQH | 430 | 5000 | 280 | 5000 | 210 | 5000 | ns |
| 6 | Pulse Width, Q Low | PWQL | 450 | 15500 | 280 | 15700 | 220 | 15700 | ns |
| 7 | Delay Time, E to Q Rise | t'AVS | 200 | 250 | 130 | 165 | 80 | 125 | ns |
| 9 | Address Hold Time* (See Note 4) | tAH | 20 | - | 20 | _ | 20 | _ | ns |
| 10 | BA, BS, R/W, and Address Valid Time to Q Rise | tAQ | 50 | - | 25 | _ | 15 | _ | ns |
| 17 | Read Data Setup Time | †DSR | 80 | - | 60 | - | 40 | - | ns |
| 18 | Read Data Hold Time* | ^t DHR | 10 | - | 10 | _ | 10 | _ | ns |
| 20 | Data Delay Time from Q | tDDQ | - | 200 | - | 140 | _ | 110 | ns |
| 21 | Write Data Hold Time* | tDHW | 30 | - | 30 | - | 30 | _ | ns |
| 29 | Usable Access Time (See Note 3) | tACC | 695 | _ | 440 | _ | 330 | _ | ns |
| | Processor Control Setup Time (MRDY, Interrupts, DMA/BREQ, HALT, RESET) (Figures 7, 9, 10, 11, 13, and 14) | tPCS | 200 | _ | 140 | - | 110 | - | ns |
| | Crystal Oscillator Start Time (Figures 7 and 8) | tRC | - | 100 | - | 100 | _ | 100 | ms |
| | Processor Control Rise and Fall Time (Figures 7 and 9) | tPCr, tPCf | - | 100 | _ | 100 | - | 100 | ns |

^{*}Address and data hold times are periodically tested rather than 100% tested

NOTES.

- 1 Voltage levels shown are V_L \leq 0 4 V, V_H \geq 2 4 V, unless otherwise specified. 2 Measurement points shown are 0 8 V and 2 0 V, unless otherwise specified
- 3 Usable access time is computed by 1 4 7 max + 10 17

 4 Hold time () I for BA and BS is not specified.

 5 Maximum t_{CYC} during MRDY or DMA/BREQ is 16 µs

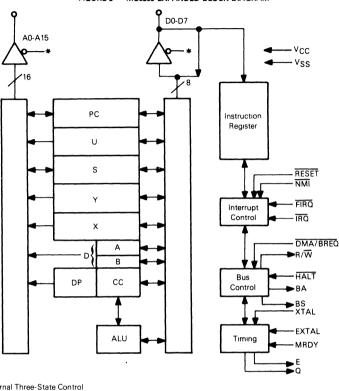
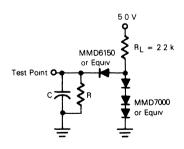


FIGURE 3 - MC6809 EXPANDED BLOCK DIAGRAM

* Internal Three-State Control

FIGURE 4 - BUS TIMING TEST LOAD



C = 30 pF for BA, BS130 pF for D0-D7, E, Q 90 pF for A0-A15, R/W $R = 11.7 k\Omega$ for D0-D7 16.5 k Ω for A0-A15, E, Q, R/ \overline{W} 24 kΩ for BA, BS

PROGRAMMING MODEL

As shown in Figure 5, the MC6809 adds three registers to the set available in the MC6800. The added registers include a Direct Page Register, the User Stack pointer and a second Index Register

ACCUMULATORS (A, B, D)

The A and B registers are general purpose accumulators which are used for arithmetic calculations and manipulation

Certain instructions concatenate the A and B registers to form a single 16-bit accumulator. This is referred to as the D Register, and is formed with the A Register as the most significant byte

DIRECT PAGE REGISTER (DP)

The Direct Page Register of the MC6809 serves to enhance the Direct Addressing Mode. The content of this register appears at the higher address outputs (A8-A15) during direct Addressing Instruction execution This allows the direct mode to be used at any place in memory, under program control To ensure 6800 compatibility, all bits of this register are cleared during Processor Reset.

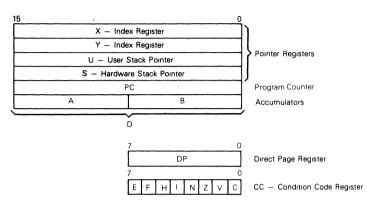


FIGURE 5 - PROGRAMMING MODEL OF THE MICROPROCESSING UNIT

INDEX REGISTERS (X, Y)

The Index Registers are used in indexed mode of addressing. The 16-bit address in this register takes part in the calculation of effective addresses. This address may be used to point to data directly or may be modified by an optional constant or register offset. During some indexed modes, the contents of the index register are incremented or decremented to point to the next item of tabular type data All four pointer registers (X, Y, U, S) may be used as index registers.

STACK POINTER (U, S)

The Hardware Stack Pointer (S) is used automatically by the processor during subroutine calls and interrupts. The stack pointers of the MC6809 point to the top of the stack, in contrast to the MC6800 stack pointer, which pointed to the next free location on the stack. The User Stack Pointer (U) is controlled exclusively by the programmer thus allowing arguments to be passed to and from subroutines with ease. Both Stack Pointers have the same indexed mode addressing capabilities as the X and Y registers, but also support Push and Pull instructions. This allows the MC6809 to be used efficiently as a stack processor, greatly enhancing its ability to support higher level languages and modular programming.

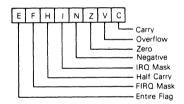
PROGRAM COUNTER

The Program Counter is used by the processor to point to the address of the next instruction to be executed by the processor. Relative Addressing is provided allowing the Program Counter to be used like an index register in some situations.

CONDITION CODE REGISTER

The Condition Code Register defines the State of the Processor at any given time. See Figure 6.

FIGURE 6 - CONDITION CODE REGISTER FORMAT



CONDITION CODE REGISTER DESCRIPTION

BIT 0 (C)

Bit 0 is the carry flag, and is usually the carry from the binary ALU. C is also used to represent a 'borrow' from subtract like instructions (CMP, NEG, SUB, SBC) and is the complement of the carry from the binary ALU.

BIT 1 (V)

Bit 1 is the overflow flag, and is set to a one by an operation which causes a signed two's complement arithmetic overflow. This overflow is detected in an operation in which the carry from the MSB in the ALU does not match the carry from the MSB-1.

BIT 2 (Z)

Bit 2 is the zero flag, and is set to a one if the result of the previous operation was identically zero

BIT 3 (N)

Bit 3 is the negative flag, which contains exactly the value of the MSB of the result of the preceding operation. Thus, a negative two's-complement result will leave N set to a one

BIT 4 (I)

Bit 4 is the \overline{IRQ} mask bit. The processor will not recognize interrupts from the \overline{IRQ} line if this bit is set to a one. \overline{NMI} , \overline{FIRQ} , \overline{IRQ} , \overline{RESET} , and SWI are set I to a one, SWI2 and SWI3 do not affect I

BIT 5 (H)

Bit 5 is the half-carry bit, and is used to indicate a carry from bit 3 in the ALU as a result of an 8-bit addition only (ADC or ADD). This bit is used by the DAA instruction to perform a BCD decimal add adjust operation. The state of this flag is undefined in all subtract-like instructions.

BIT 6 (F)

Bit 6 is the \overline{FIRQ} mask \underline{bit} The processor will not recognize interrupts from the \overline{FIRQ} line if this \underline{bit} is a one \overline{NM} , \overline{FIRQ} , SWI, and \overline{RESET} all set F to a one \overline{IRQ} , SWI2 and SWI3 do not affect F

BIT 7 (E)

Bit 7 is the entire flag, and when set to a one indicates that the complete machine state (all the registers) was stacked, as opposed to the subset state (PC and CC). The E bit of the stacked CC is used on a return from interrupt (RTI) to determine the extent of the unstacking. Therefore, the current E left in the Condition Code Register represents past action.

PIN DESCRIPTIONS

POWER (VSS, VCC)

Two pins are used to supply power to the part $~V_{SS}$ is ground or 0 volts, while VCC is $+5.0~V~\pm5\%$

ADDRESS BUS (A0-A15)

Sixteen pins are used to output address information from the MPU onto the Address Bus. When the processor does not require the bus for a data transfer, it will output address $\frac{\text{FFF}}{16}$, $R/\overline{W}=1$, and BS=0; this is a "dummy access" or $\overline{\text{VMA}}$ cycle. Addresses are valid on the rising edge of Q (see Figure 2). All address bus drivers are made high-impedance when output Bus. Available (BA) is high. Each pin will drive one Schottky TTL load or four LS TTL loads, and 90 pF.

DATA BUS (D0-D7)

These eight pins provide communication with the system bi-directional data bus. Each pin will drive one Schottky TTL load or four LS TTL loads, and 130 pF

READ/WRITE (R/W)

This signal indicates the direction of data transfer on the data bus. A low indicates that the MPU is writing data onto the data bus R/\overline{W} is made high impedance when BA is high. R/\overline{W} is valid on the rising edge of Ω

RESET

A low level on this Schmitt-trigger input for greater than one bus cycle will reset the MPU, as shown in Figure 7. The Reset vectors are fetched from locations FFFE16 and FFFF16 (Table 1) when Interrupt Acknowledge is true, $(\overline{\text{BA}} \bullet \text{BS} = 1)$. During initial power-on, the $\overline{\text{RESET}}$ line should be held low until the clock oscillator is fully operational. See Figure 8.

Because the MC6809 RESET pin has a Schmitt-trigger input with a threshold voltage higher than that of standard peripherals, a simple R/C network may be used to reset the entire system. This higher threshold voltage ensures that all peripherals are out of the reset state before the Processor

HALT

A low level on this input pin will cause the MPU to stop running at the end of the present instruction and remain halted indefinitely without loss of data. When halted, the BA output is driven high indicating the buses are high impedance. BS is also high which indicates the processor is in the Halt or Bus Grant state. While halted, the MPU will not respond to external real-time requests (FIRQ, IRQ) although DMA/BREQ will always be accepted, and NMI or RESET will be latched for later response. During the Halt state Q and E continue to run normally. If the MPU is not running (RESET, DMA/BREQ), a halted state (BA•BS = 1) can be achieved by pulling HALT low while RESET is still low. If DMA/BREQ and HALT are both pulled low, the processor will reach the last cycle of the instruction (by reverse cycle stealing) where the machine will then become halted. See Figure 9.

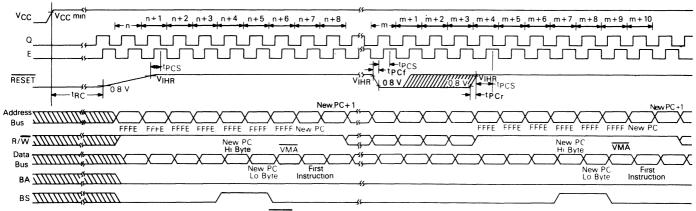
BUS AVAILABLE, BUS STATUS (BA, BS)

The Bus Available output is an indication of an internal control signal which makes the MOS buses of the MPU high impedance. This signal does not imply that the bus will be available for more than one cycle. When BA goes low, a dead cycle will elapse before the MPU acquires the bus

The Bus Status output signal, when decoded with BA, represents the MPU state (valid with leading edge of Q)

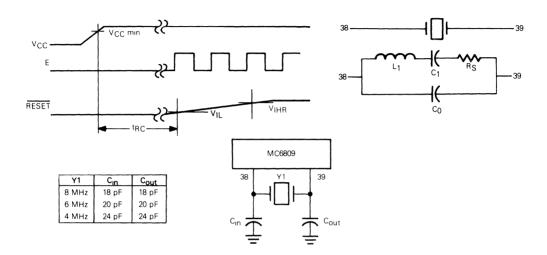
| MPU | State | MPU State Definition | |
|-----|-------|--------------------------------|--|
| BA | BS | Will O State Bellintion | |
| 0 | 0 | Normal (Running) | |
| 0 | 1 | Interrupt or Reset Acknowledge | |
| 1 | 0 | Sync Acknowledge | |
| 1 | 1 | Halt or Bus Grant Acknowledge | |





^{*}NOTE: Parts with date codes prefixed by 7F or 5A will come out of RESET one cycle sooner than shown

FIGURE 8 - CRYSTAL CONNECTIONS AND OSCILLATOR START UP

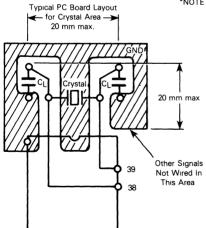


Nominal Crystal Parameters*

| | 3.58 MHz | 4.00 MHz | 6.0 MHz | 8.0 MHz |
|----------------|----------|----------|--------------|--------------|
| RS | 60 Ω | 50 Ω | 30-50 Ω | 20-40 Ω |
| c ₀ | 35 pF | 65 pF | 4-6 pF | 4-6 pF |
| C ₁ | 0 015 pF | 0 025 pF | 0 01-0 02 pF | 0 01-0 02 pF |
| a | >40K | >30 K | >20 K | > 20 K |

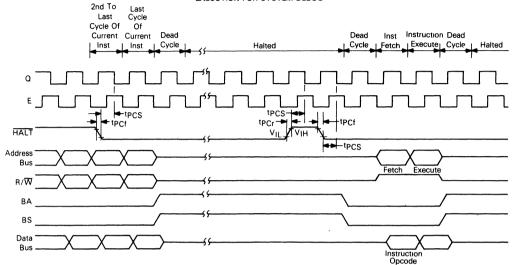
All parameters are 10%

*NOTE These are representative AT-cut crystal parameters only Crystals of other types of cut may also be used



NOTE Waveform measurements for all inputs and outputs are specified at logic high 2 0 V and logic low 0 8 V unless otherwise specified

FIGURE 9 — HALT AND SINGLE INSTRUCTION EXECUTION FOR SYSTEM DEBUG



NOTE: Waveform measurements for all inputs and outputs are specified at logic high 2.0 V and logic low 0.8 V unless otherwise specified

Interrupt Acknowledge is indicated during both cycles of a hardware-vector-fetch (RESET, NMI, FIRO, IRO, SWI, SWI2, SWI3) This signal, plus decoding of the lower four address lines, can provide the user with an indication of which interrupt level is being serviced and allow vectoring by device. See Table 1

Sync Acknowledge is indicated while the MPU is waiting for external synchronization on an interrupt line.

Halt/Bus Grant is true when the MC6809 is in a Halt or Bus Grant condition

TARLE 1: MEMORY MAP FOR INTERRUPT VECTORS

| TABLE 1. MEMORY WAF FOR INTERNOTT VECTORS | | | | | | |
|---|----------------------|------------------------------|--|--|--|--|
| , | Map For Locations | Interrupt Vector Description | | | | |
| MS | LS | Description | | | | |
| FFFE | FFFF | RESET | | | | |
| FFFC | FFFD | NMI | | | | |
| FFFA | FFFB | SWI | | | | |
| FFF8 | FFF9 | ĪRQ | | | | |
| FFF6 | FFF7 ' | FIRQ | | | | |
| FFF4 | FFF5 | SWI2 | | | | |
| FFF2 | FFF3 | SWI3 | | | | |
| FFF0 | FFF1 | Reserved | | | | |

NON MASKABLE INTERRUPT (NMI)*

A negative transition on this input requests that a non-maskable interrupt sequence be generated. A non-maskable

interrupt cannot be inhibited by the program, and also has a higher priority than $\overline{F|RQ}$, \overline{RQ} or software interrupts. During recognition of an \overline{NMI} , the entire machine state is saved on the hardware stack. After reset, an \overline{NMI} will not be recognized until the first program load of the Hardware Stack Pointer (S). The pulse width of \overline{NMI} low must be at least one E cycle. If the \overline{NMI} input does not meet the minimum set up with respect to Q, the interrupt will not be recognized until the next cycle. See Figure 10

FAST-INTERRUPT REQUEST (FIRQ)*

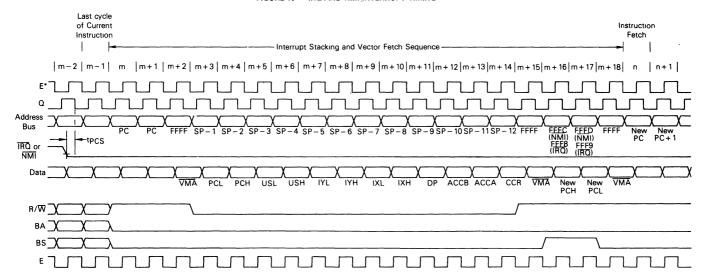
A low level on this input pin will initiate a fast interrupt sequence, provided its mask bit (F) in the CC is clear. This sequence has priority over the standard Interrupt Request (IRQ), and is fast in the sense that it stacks only the contents of the condition code register and the program counter. The interrupt service routine should clear the source of the interrupt before doing an RTI. See Figure 11.

INTERRUPT REQUEST (IRQ)*

A low level input on this pin will initiate an Interrupt Request sequence provided the mask bit (I) in the CC is clear. Since $\overline{\text{IRQ}}$ stacks the entire machine state it provides a slower response to interrupts than $\overline{\text{FIRQ}}$. $\overline{\text{IRQ}}$ also has a lower priority than $\overline{\text{FIRQ}}$. Again, the interrupt service routine should clear the source of the interrupt before doing an RTI See Figure 10

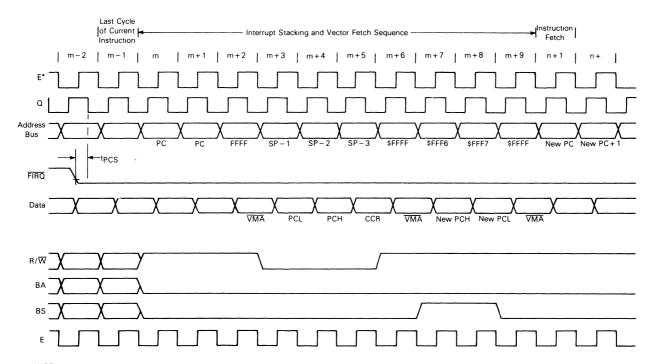
^{*}NMI, FIRQ, and IRQ requests are sampled on the falling edge of Q. One cycle is required for synchronization before these interrupts are recognized. The pending interrupt(s) will not be serviced until completion of the current instruction unless a SYNC or CWAI condition is present. If IRQ and FIRQ do not remain low until completion of the current instruction they may not be recognized. However, NMI is latched and need only remain low for one cycle. No interrupts are recognized or latched between the falling edge of RESET and the rising edge of BS indicating RESET acknowledge.

FIGURE 10 - IRQ AND NMI INTERRUPT TIMING



NOTE Waveform measurements for all inputs and outputs are specified at logic high = 2 0 V and logic low = 0 8 V unless otherwise specified E clock shown for reference only

FIGURE 11 — FIRQ INTERRUPT TIMING



NOTE Waveform measurements for all inputs and outputs are specified at logic high = 2 0 V and logic low = 0 8 V unless otherwise specified E clock shown for reference only

1

XTAL. EXTAL

These inputs are used to connect the on-chip oscillator to an external parallel-resonant crystal. Alternately, the pin EXTAL may be used as a TTL level input for external timing by grounding XTAL. The crystal or external frequency is four times the bus frequency. See Figure 8. Proper RF layout techniques should be observed in the layout of printed circuit hoards.

E. Q

E is similar to the MC6800 bus timing signal $\phi 2$, Q is a quadrature clock signal which leads E. Q has no parallel on the MC6800. Addresses from the MPU will be valid with the leading edge of Q. Data is latched on the falling edge of E. Timing for E and Q is shown in Figure 12.

MRDY*

This input control signal allows stretching of E and Q to extend data-access time E and Q operate normally while MRDY is high. When MRDY is low, E and Q may be stretched in integral multiples of quarter (¼) bus cycles, thus allowing interface to slow memories, as shown in Figure 13(A). During non-valid memory access (VMA cycles) MRDY has no effect on stretching E and Q, this inhibits slowing the processor during "don't care" bus accesses. MRDY may also be used to stretch clocks (for slow memory) when bus control has been transferred to an external device (through the use of HALT and DMA/BREQ).

NOTE Four of the early production mask sets (G7F, T5A, P6F, T6M) require synchronization of the MRDY input with the 4f clock. The synchronization necessitates an external oscillator as shown in Figure 13(B). The negative transition of the MRDY signal, normally derived from the chip select decoding, must meet the tpcs timing. With these four mask sets, MRDY's positive transition must occur with the rising edge of 4f.

In addition, on these same mask sets, MRDY will not stretch the E and Q signals if the machine is executing either a TFR or EXG instruction during the HALT high-to-low transition. If the MPU executes a CWAI instruction, the machine pushes the internal registers onto the stack and then awaits an interrupt. During this waiting period, it is possible to place

the MPU into a Halt mode to three-state the machine, but MRDY will not stretch the clocks

The mask set for a particular part may be determined by examining the markings on top of the part. Below the part number is a string of characters. The first two characters are the last two characters of the mask set code. If there are only four digits the part is the G7F mask set. The last four digits, the date code, show when the part was manufactured. These four digits represent year and week. For example a ceramic part marked.



is a T5A mask set made the twelveth week of 1980.

DMA/BREO*

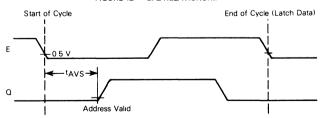
The DMA/BREQ input provides a method of suspending execution and acquiring the MPU bus for another use, as shown in Figure 14. Typical uses include DMA and dynamic memory refresh.

Transitions of $\overline{DMA/BREQ}$ should occur during Q. A low level on this pin will stop instruction execution at the end of the current cycle unless pre-empted by self-refresh. The MPU will acknowledge $\overline{DMA/BREQ}$ by setting BA and BS to a one. The requesting device will now have up to 15 bus cycles before the MPU retrieves the bus for self-refresh. Self-refresh requires one bus cycle with a leading and trailing dead cycle. See Figure 15. The self-refresh counter is only cleared if $\overline{DMA/BREQ}$ is inactive for two or more MPU cycles.

Typically, the DMA controller will request to use the bus by asserting $\overline{D}MA/BREQ$ pin low on the leading edge of E When the MPU replies by setting BA and BS to a one, that cycle will be a dead cycle used to transfer bus mastership to the DMA controller

False memory accesses may be prevented during any dead cycles by developing a system \overline{DMAVMA} signal which is LOW in any cycle when BA has changed

FIGURE 12 - E/Q RELATIONSHIP



NOTE. Waveform measurements for all inputs and outputs are specified at logic high 2.0 V and logic low 0.8 V unless otherwise specified

^{*}The on-board clock generator furnishes E and Q to both the system and the MPU. When MRDY is pulled low, both the system clocks and the internal MPU clocks are stretched. Assertion of \$\overline{DMA/BREQ}\$ input stops the internal MPU clocks while allowing the external system clocks to RUN (i.e., release the bus to a DMA controller). The internal MPU clocks resume operation after \$\overline{DMA/BREQ}\$ is released or after 16 bus cycles (14 DMA, 2 dead), whichever occurs first. While \$\overline{DMA/BREQ}\$ is asserted it is sometimes necessary to pull MRDY low to allow DMA to/from slow me nory/peripherals. As both MRDY and \$\overline{DMA/BREQ}\$ control the internal MPU clocks, care must be exercised not to violate the maximum \$t_{CVC}\$ specification for MRDY or \$\overline{DMA/BREQ}\$ (See Note 5 in Bus Timing.)

When BA goes low (either as a result of DMA/BREQ = HIGH or MPU self-refresh), the DMA device should be taken off the bus Another dead cycle will elapse before the MPU accesses memory, to allow transfer of bus mastership without contention

MPU OPERATION

During normal operation, the MPU fetches an instruction from memory and then executes the requested function.

This sequence begins after RESET and is repeated indefinitely unless altered by a special instruction or hardware occurrence. software instructions that alter normal MPU operation are: SWI, SWI3, SWI3, CWAI, RTI and SYNC. An interrupt, HALT, or DMA/BREQ can also alter the normal execution of instructions. Figure 16 illustrates the flowchart for the MC6809.

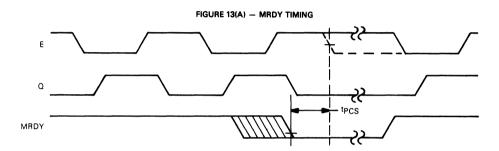
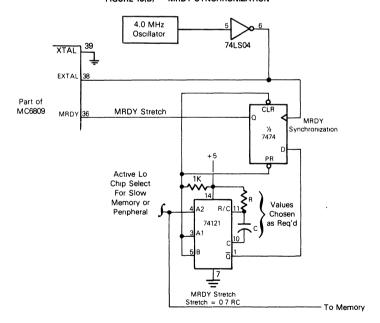


FIGURE 13(B) - MRDY SYNCHRONIZATION



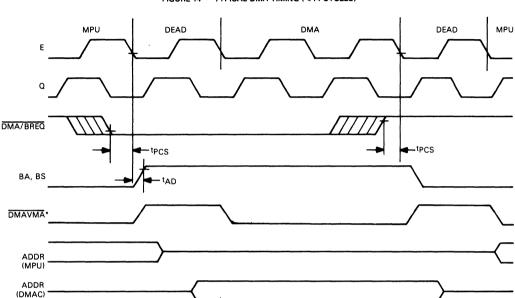
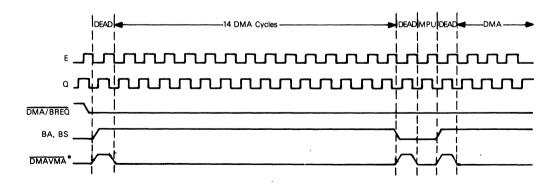


FIGURE 14 - TYPICAL DMA TIMING (<14 CYCLES)

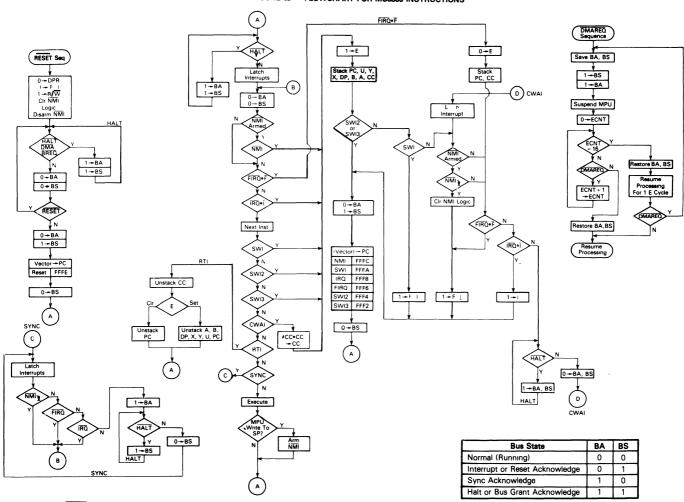
FIGURE 15 — AUTO-REFRESH DMA TIMING (> 14 CYCLES) (REVERSE CYCLE STEALING)



^{*}DMAVMA is a signal which is developed externally, but is a system requirement for DMA. Refer to Application Note AN-8.

NOTE: Waveform measurements for all inputs and outputs are specified at logic high 2 0 V and logic low 0.8 V unless otherwise specified

FIGURE 16 - FLOWCHART FOR MC6809 INSTRUCTIONS



NOTE: Asserting RESET will result in entering the reset sequence from any point in the flow chart.

ADDRESSING MODES

The basic instructions of any computer are greatly enhanced by the presence of powerful addressing modes. The MC6809 has the most complete set of addressing modes available on any microcomputer today. For example, the MC6809 has 59 basic instructions; however, it recognizes 1464 different variations of instructions and addressing modes. The addressing modes support modern programming techniques. The following addressing modes are available on the MC6809:

Inherent (Includes Accumulator)

Immediate

Extended

Extended Indirect

Direct

Register

Indexed

Zero-Offset

Constant Offset

Accumulator Offset

Auto Increment/Decrement

Indexed Indirect

Relative

Short/Long Relative Branching

Program Counter Relative Addressing

INHERENT (INCLUDES ACCUMULATOR)

In this addressing mode, the opcode of the instruction contains all the address information necessary Examples of Inherent Addressing are ABX, DAA, SWI, ASRA, and CLRB

IMMEDIATE ADDRESSING

In Immediate Addressing, the effective address of the data is the location immediately following the opcode (i.e., the data to be used in the instruction immediately follows the opcode of the instruction). The MC6809 uses both 8 and 16-bit immediate values depending on the size of argument specified by the opcode. Examples of instructions with Immediate Addressing are:

LDA #\$20

LDX #\$F000

LDY #CAT

NOTE: # signifies Immediate addressing, \$ signifies hexadecimal value.

EXTENDED ADDRESSING

In Extended Addressing, the contents of the two bytes immediately following the opcode fully specify the 16-bit effective address used by the instruction. Note that the address generated by an extended instruction defines an absolute address and is not position independent. Examples of Extended Addressing include

LDA CAT

STX MOUSE

LDD \$2000

EXTENDED INDIRECT

As a special case of indexed addressing (discussed below), one level of indirection may be added to Extended Addressing. In Extended Indirect, the two bytes following the postbyte of an Indexed instruction contain the address of the data.

LDA [CAT]

LDX [\$FFFE]

STU [DOG]

DIRECT ADDRESSING

Direct addressing is similar to extended addressing except that only one byte of address follows the opcode. This byte specifies the lower 8 bits of the address to be used. The upper 8 bits of the address are supplied by the direct page register. Since only one byte of address is required in direct addressing, this mode requires less memory and executes faster than extended addressing. Of course, only 256 locations (one page) can be accessed without redefining the contents of the DP register. Since the DP register is set to \$00 on Reset, direct addressing on the MC6809 is compatible with direct addressing on the M6800. Indirection is not allowed in direct addressing. Some examples of direct addressing are

LDA \$30

SETDP \$10 (Assembler directive)

LDB \$1030

LDD < CAT

NOTE: < is an assembler directive which forces direct addressing

REGISTER ADDRESSING

Some opcodes are followed by a byte that defines a register or set of registers to be used by the instruction. This is called a postbyte. Some examples of register addressing

TFR X, Y Transfers X into Y
EXG A, B Exchanges A with B
PSHS A, B, X, Y Push Y, X, B and A onto S

Pull D, X, and Y from U

INDEXED ADDRESSING

X, Y, D

PULU

In all indexed addressing, one of the pointer registers (X, Y, U, S, and sometimes PC) is used in a calculation of the effective address of the operand to be used by the instruction Five basic types of indexing are available and are discussed below. The postbyte of an indexed instruction specifies the basic type and variation of the addressing mode as well as the pointer register to be used. Figure 17 lists the legal formats for the postbyte. Table 2 gives the assembler form and the number of cycles and bytes added to the basic values for indexed addressing for each variation.

FIGURE 17 - INDEXED ADDRESSING POSTBYTE REGISTER BIT ASSIGNMENTS

| | 1 | ost- | Byte | Regis | Indexed | | | |
|---|---|------|------|-------|---------|---|---|--------------------------|
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | Addressing Mode |
| 0 | R | R | d | d | d | d | d | EA = ,R + 5 Bit Offset |
| 1 | R | R | 0 | 0 | 0 | 0 | 0 | ,R+ |
| 1 | R | R | - 1 | 0 | 0 | 0 | 1 | ,R++ |
| 1 | R | R | 0 | 0 | 0 | 1 | 0 | , – R |
| 1 | R | R | 1 | 0 | 0 | 1 | 1 | , – – R |
| 1 | R | R | 1 | 0 | 1 | 0 | 0 | EA = R + 0 Offset |
| 1 | R | R | 1 | 0 | 1 | 0 | 1 | EA = ,R + ACCB Offset |
| 1 | R | R | 1 | 0 | 1 | 1 | 0 | EA = ,R + ACCA Offset |
| 1 | R | R | - 1 | 1 | 0 | 0 | 0 | EA = ,R +8 Bit Offset |
| 1 | R | R | - 1 | 1 | 0 | 0 | 1 | EA = ,R + 16 Bit Offset |
| 1 | R | R | 1 | 1 | 0 | 1 | 1 | EA = ,R + D Offset |
| 1 | × | x | - 1 | 1 | 1 | 0 | 0 | EA = ,PC +8 Bit Offset |
| 1 | х | × | _ | 1 | 1 | 0 | 1 | EA = ,PC + 16 Bit Offset |
| 1 | R | R | 1 | 1 | 1 | 1 | 1 | EA = [,Address] |

Addressing Mode Field Indirect Field (Sign bit when $b_7 = 0$)

Register Field RR

00 = X01 = Y

10 = U

11 = S

x = Don't Care d = Offset Bit

0 = Not Indirect 1 = Indirect

Zero-Offset Indexed - In this mode, the selected pointer register contains the effective address of the data to be used by the instruction. This is the fastest indexing mode.

Examples are

LDD 0,X LDA

Constant Offset Indexed - In this mode, a two's-complement offset and the contents of one of the pointer registers are added to form the effective address of the operand The pointer register's initial content is unchanged by the addition

Three sizes of offsets are available.

5 -bit (-16 to +15)

8 -bit (-128 to +127)

16-bit (-32768 to +32767)

The two's complement 5-bit offset is included in the postbyte and, therefore, is most efficient in use of bytes and cycles. The two's complement 8-bit offset is contained in a single byte following the postbyte. The two's complement 16-bit offset is in the two bytes following the postbyte. In most cases the programmer need not be concerned with the size of this offset since the assembler will select the optimal size automatically.

Examples of constant-offset indexing are

LDA

-2,SLDX LDY 300,X

23.X

LDU CAT.Y

TABLE 2 - INDEXED ADDRESSING MODE

| | | No | n Indirect | | | Indirect | | |
|----------------------------|-------------------|-------------------|---------------------|------------|-------------------|---------------------|---|--------|
| Туре | Forms | Assembler Form | Postbyte OP Code | + + ~ # | Assembler Form | Postbyte OP Code | + | + # |
| Constant Offset From R | No Offset | ,R | 1RR00100 | 0 0 | [,R] | 1RR10100 | 3 | 0 |
| (2's Complement Offsets) | 5 Bit Offset | n, R | 0RRnnnnn | 1 0 | defaults | to 8-bit | | |
| | 8 Bit Offset | n, R | 1RR01000 | 1 1 | [n, R] | 1RR11000 | 4 | 1 |
| | 16 Bit Offset | n, R | 1RR01001 | 4 2 | [n, R] | 1RR11001 | 7 | 2 |
| Accumulator Offset From R | A Register Offset | A, R | 1RR00110 | 1 0 | [A, R] | 1RR10110 | 4 | 0 |
| (2's Complement Offsets) | B Register Offset | B, R | 1RR00101 | 1 0 | [B, R] | 1RR10101 | 4 | 0 |
| | D Register Offset | D, R | 1RR01011 | 4 0 | [D, R] | 1RR11011 | 7 | 0 |
| Auto Increment/Decrement R | Increment By 1 | ,R+ | 1RR00000 | 2 0 | not allowed | | Π | |
| | Increment By 2 | ,R++ | 1RR00001 | 3 0 | [,R++] | 1RR10001 | 6 | 0 |
| | Decrement By 1 | , – R | 1RR00010 | 2 0 | not al | lowed | | |
| | Decrement By 2 | , – – R | . 1RR00011 | 3 0 | [, R] | 1RR10011 | 6 | 0 |
| Constant Offset From PC | 8 Bit Offset | n, PCR | 1xx01100 | 1 1 | [n, PCR] | 1xx11100 | 4 | 1 |
| (2's Complement Offsets) | 16 Bit Offset | n, PCR | 1xx01101 | 5 2 | [n, PCR] | 1xx11101 | 8 | 2 |
| Extended Indirect | 16 Bit Address | _ | _ | | [n] | 10011111 | 5 | 2 |

R = X, Y, U or S

x = Don't Care

RR 00 = X

01 = Y

10 = U 11 = S

and $\frac{1}{4}$ indicate the number of additional cycles and bytes for the particular variation

Accumulator-Offset Indexed — This mode is similar to constant offset indexed except that the two's-complement value in one of the accumulators (A, B or D) and the contents of one of the pointer registers are added to form the effective address of the operand. The contents of both the accumulator and the pointer register are unchanged by the addition. The postbyte specifies which accumulator to use as an offset and no additional bytes are required. The advantage of an accumulator offset is that the value of the offset can be calculated by a program at run-time.

Some examples are:

LDA B,Y LDX D,Y LEAX B,X

Auto Increment/Decrement Indexed — In the auto increment addressing mode, the pointer register contains the address of the operand. Then, after the pointer register is used it is incremented by one or two. This addressing mode is useful in stepping through tables, moving data, or for the creation of software stacks. In auto decrement, the pointer register is decremented prior to use as the address of the data. The use of auto decrement is similar to that of auto increment; but the tables, etc., are scanned from the high to low addresses. The size of the increment/decrement can be either one or two to allow for tables of either 8 or 16-bit data to be accessed and is selectable by the programmer. The pre-decrement, post-increment nature of these modes allow them to be used to create additional software stacks that behave identically to the U and S stacks.

Some examples of the auto increment/decrement addressing modes are:

LDA ,X+ STD ,Y++ LDB ,-Y LDX ,--S

Care should be taken in performing operations on 16-bit pointer registers (X, Y, U, S) where the same register is used to calculate the effective address.

Consider the following instruction:

STX 0,X++ (X initialized to 0)

The desired result is to store a 0 in locations \$0000 and \$0001 then increment X to point to \$0002. In reality, the following occurs:

 $0 \rightarrow \text{temp}$ calculate the EA, temp is a holding register $X + 2 \rightarrow X$ perform autoincrement $X \rightarrow \{\text{temp}\}$ do store operation

INDEXED INDIRECT

All of the indexing modes with the exception of auto increment/decrement by one, or a ± 4 -bit offset may have an additional level of indirection specified. In indirect adddressing, the effective address is contained at the location specified by the contents of the Index register plus any offset. In the example below, the A accumulator is loaded indirectly using an effective address calculated from the Index register and an offset.

Before Execution
A = XX (don't care)
X = \$F000
\$0100 LDA [\$10,X] EA is now \$F010
\$F010 \$F1 \$F150 is now the \$F011 \$50 new EA
\$F150 \$AA
After Execution
A = \$AA Actual Data Loaded
X = \$F000

All modes of indexed indirect are included except those which are meaningless (e.g., auto increment/decrement by 1 indirect). Some examples of indexed indirect are

LDA [,X] LDA [B,Y] LDD [10.S] LDD [,X++]

RELATIVE ADDRESSING

The byte(s) following the branch opcode is (are) treated as a signed offset which may be added to the program counter. If the branch condition is true then the calculated address (PC + signed offset) is loaded into the program counter. Program execution continues at the new location as indicated by the PC, short (1 byte offset) and long (2 bytes offset) relative addressing modes are available. All of memory can be reached in long relative addressing as an effective address is interpreted modulo 216. Some examples of relative addressing are:

BEQ CAT (short) BGT DOG (short) CAT LBEQ RAT (long) DOG LBGT RABBIT (long) RAT NOP RABBIT NOP

PROGRAM COUNTER RELATIVE

The PC can be used as the pointer register with 8 or 16-bit signed offsets. As in relative addressing, the offset is added to the current PC to create the effective address. The effective address is then used as the address of the operand or data. Program Counter Relative Addressing is used for writing position independent programs. Tables related to a particular routine will maintain the same relationship after the routine is moved, if referenced relative to the Program Counter. Examples are:

LDA CAT, PCR LEAX TABLE, PCR

Since program counter relative is a type of indexing, an additional level of indirection is available

LDA [CAT, PCR] LDU [DOG, PCR]

MC6809 INSTRUCTION SET

The instruction set of the MC6809 is similar to that of the MC6800 and is upward compatible at the source code level. The number of opcodes has been reduced from 72 to 59, but because of the expanded architecture and additional addressing modes, the number of available opcodes (with different addressing modes) has risen from 197 to 1464

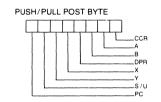
Some of the new instructions are described in detail below

PSHU/PSHS

The push instructions have the capability of pushing onto either the hardware stack (S) or user stack (U) any single register, or set of registers with a single instruction.

PULU/PULS

The pull instructions have the same capability of the push instruction, in reverse order. The byte immediately following the push or pull opcode determines which register or registers are to be pushed or pulled. The actual PUSH/PULL sequence is fixed, each bit defines a unique register to push or pull, as shown below.





TFR/EXG

Within the MC6809, any register may be transferred to or exchanged with another of like-size, i.e., 8-bit to 8-bit or 16-bit to 16-bit. Bits 4-7 of postbyte define the source

register, while bits 0-3 represent the destination register. These are denoted as follows.

TRANSFER/EXCHANGE POST BYTE

| REGISTER | FIELD | |
|--------------|--------|-----|
| 0000 D (A B) | 1000 - | Α |
| 0001 = X | 1001 - | В |
| 0010 - Y | 1010 | CCR |
| 0011 - U | 1011 | DPR |
| 0100 S | | |

SOURCE DESTINATION

NOTE: All other combinations are undefined and INVALID

LEAX/LEAY/LEAU/LEAS

0101 PC

The LEA (Load Effective Address) works by calculating the effective address used in an indexed instruction and stores that address value, rather than the data at that address, in a pointer register. This makes all the features of the internal addressing hardware available to the programmer Some of the implications of this instruction are illustrated in Table 3.

The LEA instruction also allows the user to access data and tables in a position independent manner. For example.

LEAX MSG1, PCR
LBSR PDATA (Print message routine)

MSG1 FCC 'MESSAGE'

This sample program prints 'MESSAGE' By writing MSG1, PCR, the assembler computes the distance between the present address and MSG1. This result is placed as a constant into the LEAX instruction which will be indexed from the PC value at the time of execution. No matter where the code is located, when it is executed, the computed offset from the PC will put the absolute address of MSG1 into the X pointer register. This code is totally position independent.

The LEA instructions are very powerful and use an internal holding register (temp). Care must be exercised when using the LEA instructions with the autoincrement and autodecrement addressing modes due to the sequence of internal operations. The LEA internal sequence is outlined as follows:

LEAa ,b+ (any of the 16-bit pointer registers X, Y, U, or S may be substituted for a and b)

1 b→temp (calculate the EA)
2. b+1→b (modify b, postincrement)

3 temp→a (load a)

TABLE 3 - LEA EXAMPLES

| TABLE 3 — LEA LAAMII LES | | | | | | |
|--------------------------|-----------------------|--------------------------------|--|--|--|--|
| Instruction | Operation | Comment | | | | |
| LEAX 10, X | X + 10 → X | Adds 5-bit constant 10 to X | | | | |
| LEAX 500, X | X + 500 → X | Adds 16-bit constant 500 to X | | | | |
| LEAY A, Y | Y + A → Y | Adds 8-bit A accumulator to Y | | | | |
| LEAY D, Y | $Y + D \rightarrow Y$ | Adds 16-bit D accumulator to Y | | | | |
| LEAU - 10, U | U - 10 → U | Subtracts 10 from U | | | | |
| LEAS - 10, S | S - 10 → S | Used to reserve area on stack | | | | |
| LEAS 10, S | S + 10 → S | Used to 'clean up' stack | | | | |
| LEAX 5, S | S + 5 → X | Transfers as well as adds | | | | |

MC6809 • MC68A09 • MC68B09

LEAa,-b

1 b-1→temp (calculate EA with predecrement)

 $2 b-1\rightarrow b$ (modify b, predecrement)

3 temp→a (load a)

Autoincrement-by-two and autodecrement-by-two instructions work similarly. Note that LEAX ,X + does not change X, however LEAX, -X does decrement LEAX 1, X should be used to increment X by one

MUL

Multiplies the unsigned binary numbers in the A and B accumulator and places the unsigned result into the 16-bit D accumulator. This unsigned multiply also allows multiple-precision multiplications.

Long And Short Relative Branches

The MC6809E has the capability of program counter relative branching throughout the entire memory map. In this mode, if the branch is to be taken, the 8- or 16-bit signed offset is added to the value of the program counter to be used as the effective address. This allows the program to branch anywhere in the 64K memory map. Position-independent code can be easily generated through the use of relative branching. Both short (8-bit) and long (16-bit) branches are available.

SYNC

After encountering a Sync instruction, the MPU enters a Sync state, stops processing instructions and waits for an interrupt. If the pending interrupt is non-maskable (RMI) or maskable (FIRQ, IRQ) with its mask bit (F or I) clear, the processor will clear the Sync state and perform the normal interrupt stacking and service routine. Since FIRQ and IRQ are not edge-triggered, a low level with a minimum duration of three bus cycles is required to assure that the interrupt will be taken. If the pending interrupt is maskable (FIRQ, IRQ) with its mask bit (F or I) set, the processor will clear the Sync state and continue processing by executing the next inline instruction. Figure 18 depicts Sync timing

Software Interrupts

A Software Interrupt is an instruction which will cause an interrupt, and its associated vector fetch. These Software Interrupts are useful in operating system calls, software debugging, trace operations, memory mapping, and software development systems. Three levels of SWI are available on the MC6809, and are prioritized in the following order SWI, SWI2, SWI3

16-Bit Operation

The MC6809 has the capability of processing 16-bit data These instructions include loads, stores, compares, adds, subtracts, transfers, exchanges, pushes and pulls

CYCLE-BY-CYCLE OPERATION

The address bus cycle-by-cycle performance chart illustrates the memory-access sequence corresponding to each possible instruction and addressing mode in the MC6809 Each instruction begins with an opcode fetch While that opcode is being internally decoded, the next program byte is always fetched (Most instructions will use the

next byte, so this technique considerably speeds throughput I Next, the operation of each opcode will follow the flowchart VMA is an indication of FFFF16 on the address bus, R/W=1 and BS=0 The following examples illustrate the use of the chart, see Figure 19

Example 1: LBSR (Branch Taken)
Before Execution SP = F000

| | | • | |
|--------|-----|------|-----|
| | | • | |
| | | • | |
| \$8000 | | LBSR | CAT |
| | | • | |
| | | • | |
| | | • | |
| \$A000 | CAT | • | |
| | | | |

CYCLE-BY-CYCLE FLOW

| CTCLL-BT-CTCLL TEOW | | | | | | | | |
|---------------------|---------|------|------------------|--------------------------|--|--|--|--|
| Cycle # | Address | Data | R/\overline{W} | Description | | | | |
| 1 | 8000 | 17 | 1 | Opcode Fetch | | | | |
| 2 | 8001 | 20 | 1 | Offset High Byte | | | | |
| 3 | 8002 | 00 | 1 | Offset Low Byte | | | | |
| 4 | FFFF | • | 1 | VMA Cycle | | | | |
| 5 | FFFF | • | 1 | VMA Cycle | | | | |
| 6 | A000 | • | 1 | Computed Branch Address | | | | |
| 7 | FFFF | • | 1 | VMA Cycle | | | | |
| 8 | EFFF | 80 | 0 | Stack High Order Byte of | | | | |
| | | | | Return Address | | | | |
| 9 | EFFE | 03 | 0 | Stack Low Order Byte of | | | | |
| | | | | Return Address | | | | |

Example 2: DEC (Extended)

| \$8000 | DEC | \$A000 |
|---------|------|--------|
| | | |
| \$A8000 | \$80 | |

CYCLE-BY-CYCLE FLOW

| Cycle # | Address | Data | R/\overline{W} | Description |
|---------|---------|------|------------------|----------------------------|
| 1 | 8000 | 7A | 1 | Opcode Fetch |
| 2 | 8001 | A0 | 1 | Operand Address, High Byte |
| 3 | 8002 | 00 | 1 | Operand Address, Low Byte |
| 4 | FFFF. | • | 1 | VMA Cycle |
| 5 | A000 | 80 | 1 | Read the Data |
| 6 | FFFF | • | 1 | VMA Cycle |
| 7 | A000 | 7F | 0 | Store the Decremented Data |

^{*}The data bus has the data at that particular address

MC6809 INSTRUCTION SET TABLES

The instructions of the MC6809 have been broken down into five different categories. They are as follows

8-Bit operation (Table 4)

16-Bit operation (Table 5)

Index register/stack pointer instructions (Table 6)

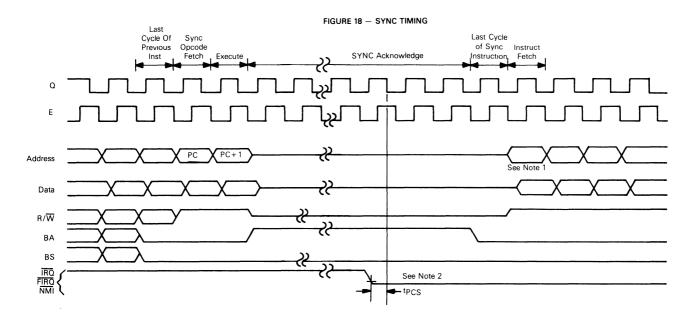
Relative branches (long or short) (Table 7)

Miscellaneous instructions (Table 8)

Hexadecimal values for the instructions are given in Table 9

PROGRAMMING AID

Figure 21 contains a compilation of data that will assist in programming the MC6809



NOTES

- 1 If the associated mask bit is set when the interrupt is requested, this cycle will be an instruction fetch from address location PC+1. However, if the interrupt is accepted (NMI) or an unmasked FIRQ or IRQ) interrupt processing continues with this cycle as (m) on Figures 10 and 11 (Interrupt Timing)
- 2 If mask bits are clear, IRQ and FIRQ must be held low for three cycles to guarantee interrupt to be taken, although only one cycle is necessary to bring the processor out of SYNC

NOTE Waveform measurements for all inputs and outputs are specified at logic high 2 0 V and logic low 0 8 V unless otherwise specified

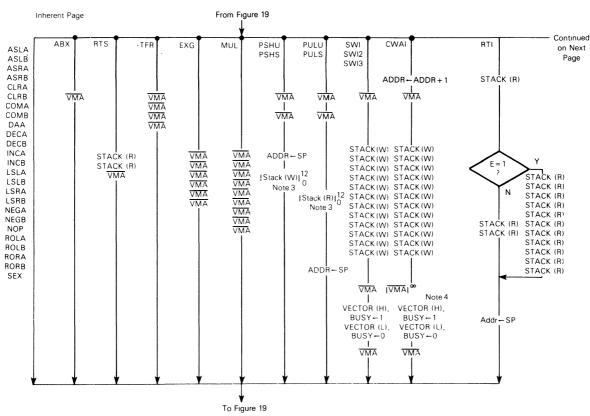
FIGURE 19 - ADDRESS BUS CYCLE-BY-CYCLE PERFORMANCE Fetch ADDR - Address of Opcode (Fetch) Addr -- Addr + 1 5age or 3 (Note 1) Prebyte Indexed Short Long Immediate and Branch Direct Extended Branch Inherent Addr - Addr + 1 Auto Aut Inc/Dec Inc/Dec Extended PC+ No VMA Addr - Addr + 1 by 1 by 2 R + 16 Bits ₩ R + D Addr - Addr + 1 16 Bits Indirect Offset VMA Offset ACCA ACCB ADDR- ADDR- ADDR-1 R+5 Bit R+8 Bit ADDR+1 ADDR+1 ADDR+1 PC+8 Bit ADDR← ADDR← ADDR- ADDR-VMA ADDR+1 ADDR+1 ADDR+1'ADDR+1 Take VMA VMA Jump? Branch? VMĀ VMA VMA VMA (Note 2) Addr - Address of Operand ADDR - New Opcode ADDR Operation Indirect? See Figure 20 Indirect (H) (a) or (b) VMA Indirect (L) Stack Write VMĀ Stack Write Fetch

NOTES

- 1 All subsequent Page 2 and Page 3 pre-bytes will be ignored after initial opcode fetch
- 2 Write operation during store instruction
- 3 ADDR refers to the state of the address bus

VMA

FIGURE 20(a) - OPERATION: ADDRESS BUS CYCLE-BY-CYCLE PERFORMANCE



NOTES

- 1 Stack (W) refers to the following sequence SP-SP-1, then ADDR-SP with R/W=0 Stack (R) refers to the following sequence ADDR-SP with R/W=1, then SP-SP+1 PSHU, PULU instructions use the user stack pointer (i.e., SP≡U) and PSHS PULS use the hardware stack pointer (i.e., SP≡S)
- 2 Vector refers to the address of an interrupt or reset vector (see Table 1)
- 3 The number of stack accesses will vary according to the number of bytes saved
- 4 VMA cycles will occur until an interrupt occurs

FIGURE 20(b) — OPERATION: ADDRESS BUS CYCLE-BY-CYCLE PERFORMANCE (CONTINUED)

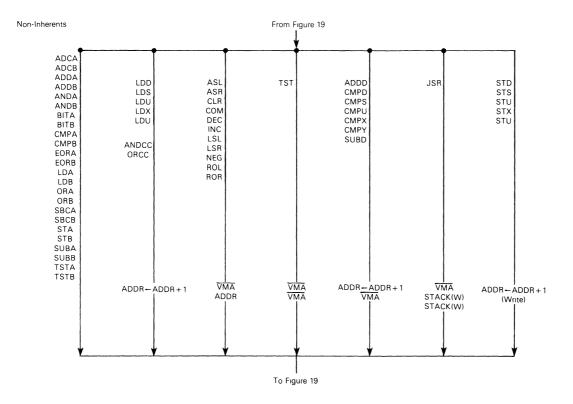


TABLE 4 - 8-BIT ACCUMULATOR AND MEMORY INSTRUCTIONS

| Mnemonic(s) | Operation |
|-----------------|--|
| ADCA, ADCB | Add memory to accumulator with carry |
| ADDA, ADDB | Add memory to accumulator |
| ANDA, ANDB | And memory with accumulator |
| ASL, ASLA, ASLB | Arithmetic shift of accumulator or memory left |
| ASR, ASRA, ASRB | Arithmetic shift of accumulator or memory right |
| BITA, BITB | Bit test memory with accumulator |
| CLR, CLRA, CLRB | Clear accumulator or memory location |
| СМРА, СМРВ | Compare memory from accumulator |
| СОМ, СОМА, СОМВ | Complement accumulator or memory location |
| DAA | Decimal adjust A accumulator |
| DEC, DECA, DECB | Decrement accumulator or memory location |
| EORA, EORB | Exclusive or memory with accumulator |
| EXG R1, R2 | Exchange R1 with R2 (R1, R2 = A, B, CC, DP) |
| INC, INCA, INCB | Increment accumulator or memory location |
| LDA, LDB | Load accumulator from memory |
| LSL, LSLA, LSLB | Logical shift left accumulator or memory location |
| LSR, LSRA, LSRB | Logical shift right accumulator or memory location |
| MUL | Unsigned multiply (A \times B \rightarrow D) |
| NEG, NEGA, NEGB | Negate accumulator or memory |
| ORA, ORB | Or memory with accumulator |
| ROL, ROLA, ROLB | Rotate accumulator or memory left |
| ROR, RORA, RORB | Rotate accumulator or memory right |
| SBCA, SBCB | Subtract memory from accumulator with borrow |
| STA, STB | Store accumulator to memory |
| SUBA, SUBB | Subtract memory from accumulator |
| TST, TSTA, TSTB | Test accumulator or memory location |
| TFR R1, R2 | Transfer R1 to R2 (R1, R2 = A, B, CC, DP) |

NOTE A, B, CC or DP may be pushed to (pulled from) either stack with PSHS, PSHU (PULS, PULU) instructions

TABLE 5 - 16-BIT ACCUMULATOR AND MEMORY INSTRUCTIONS

| TABLE 5 - 16-BIT ACCUMULATOR AND MEMORY INSTRUCTIONS | | |
|--|--|--|
| Mnemonic(s) | Operation | |
| ADDD | Add memory to D accumulator | |
| CMPD | Compare memory from D accumulator | |
| EXG D, R | Exchange D with X, Y, S, U or PC | |
| LDD | Load D accumulator from memory | |
| SEX | Sign Extend B accumulator into A accumulator | |
| STD | Store D accumulator to memory | |
| SUBD | Subtract memory from D accumulator | |
| TFR D, R | Transfer D to X, Y, S, U or PC | |
| TFR R, D | Transfer X, Y, S, U or PC to D | |

NOTE D may be pushed (pulled) to either stack with PSHS, PSHU (PULS, PULU) instructions

TABLE 6 — INDEX REGISTER/STACK POINTER INSTRUCTIONS

| TABLE 6 - INDEX REGISTER/STACK POINTER INSTRUCTIONS | | |
|---|--|--|
| Instruction | Description | |
| CMPS, CMPU | Compare memory from stack pointer | |
| CMPX, CMPY | Compare memory from index register | |
| EXG R1, R2 | Exchange D, X, Y, S, U or PC with D, X, Y, S, U or PC | |
| LEAS, LEAU | Load effective address into stack pointer | |
| LEAX, LEAY | Load effective address into index register | |
| LDS, LDU | Load stack pointer from memory | |
| LDX, LDY | Load index register from memory | |
| PSHS | Push A, B, CC, DP, D, X, Y, U, or PC onto hardware stack | |
| PSHU | Push A, B, CC, DP, D, X, Y, S, or PC onto user stack | |
| PULS | Pull A, B, CC, DP, D, X, Y, U or PC from hardware stack | |
| PULU | Pull A, B, CC, DP, D, X, Y, S or PC from hardware stack | |
| STS, STU | Store stack pointer to memory | |
| STX, STY | Store index register to memory | |
| TFR R1, R2 | Transfer D, X, Y, S, U or PC to D, X, Y, S, U or PC | |
| ABX | Add B accumulator to X (unsigned) | |

TABLE 7 - BRANCH INSTRUCTIONS

| Instruction | Description |
|-------------|--|
| | SIMPLE BRANCHES |
| BEQ, LBEQ | Branch if equal |
| BNE, LBNE | Branch if not equal |
| BMI, LBMI | Branch if minus |
| BPL, LBPL | Branch if plus |
| BCS, LBCS | Branch if carry set |
| BCC, LBCC | Branch if carry clear |
| BVS, LBVS | Branch if overflow set |
| BVC, LBVC | Branch if overflow clear |
| | SIGNED BRANCHES |
| BGT, LBGT | Branch if greater (signed) |
| BVS, LBVS | Branch if invalid 2's complement result |
| BGE, LBGE | Branch if greater than or equal (signed) |
| BEQ, LBEQ | Branch if equal |
| BNE, LBNE | Branch if not equal |
| BLE, LBLE | Branch if less than or equal (signed) |
| BVC, LBVC | Branch if valid 2's complement result |
| BLT, LBLT | Branch if less than (signed) |
| | UNSIGNED BRANCHES |
| BHI, LBHI | Branch if higher (unsigned) |
| BCC, LBCC | Branch if higher or same (unsigned) |
| BHS, LBHS | Branch if higher or same (unsigned) |
| BEQ, LBEQ | Branch if equal |
| BNE, LBNE | Branch if not equal |
| BLS, LBLS | Branch if lower or same (unsigned) |
| BCS, LBCS | Branch if lower (unsigned) |
| BLO, LBLO | Branch if lower (unsigned) |
| | OTHER BRANCHES |
| BSR, LBSR | Branch to subroutine |
| BRA, LBRA | Branch always |
| BRN, LBRN | Branch never |

TABLE 8 - MISCELLANEOUS INSTRUCTIONS

| Instruction | Description | |
|-----------------|--|---|
| ANDCC | AND condition code register | |
| CWAI | AND condition code register, then wait for interrupt | _ |
| NOP | No operation | |
| ORCC | OR condition code register | |
| JMP | Jump | |
| JSR | Jump to subroutine | |
| RTI | Return from interrupt | |
| RTS | Return from subroutine | _ |
| SWI, SWI2, SWI3 | Software interrupt (absolute indirect) | |
| SYNC | Synchronize with interrupt line | |

TABLE 9 - HEXADECIMAL VALUES OF MACHINE CODES

| OP | Mnem | Mode | ~ | # | OP | Mnem | Mode | ~ | # | OP | Mnem | Mode | ~ | # |
|----------|----------|----------|--------|---|----------|--------------|-----------------------------|------|-----|----------|----------|--------------|----|----|
| 00 | NEG | Direct | 6 | 2 | 30 | LEAX | Indexed | 4+ | 2+ | 60 | NEG | Indexed | 6+ | 2+ |
| 01 | • | A | | | 31 | LEAY | A | 4+ | 2+ | 61 | • | A | | |
| 02 | • | 1 | | | 32 | LEAS | Ţ | 4+ | 2+ | 62 | • | 1 | | |
| 03 | СОМ | | 6 | 2 | 33 | LEAU | Indexed | 4+ | 2+ | 63 | COM | l | 6+ | 2+ |
| 04 | LSR | į. | 6 | 2 | 34 | PSHS | Inherent | 5+ | 2 | 64 | LSR | | 6+ | 2+ |
| 05 | • | | • | _ | 35 | PULS | A | 5+ | 2 | 65 | • | 1 | | |
| 06 | ROR | | 6 | 2 | 36 | PSHU | - 1 | 5+ | 2 | 66 | ROR | 1 | 6+ | 2+ |
| 07 | ASR | | 6 | 2 | 37 | PULU | İ | 5+ | 2 | 67 | ASR | 1 | 6+ | 2+ |
| 08 | ASL, LSL | | 6 | 2 | 38 | • | l | • | | 68 | ASL, LSL | İ | 6+ | 2+ |
| 09 | ROL | | 6 | 2 | 39 | RTS | į. | 5 | 1 | 69 | ROL | ! | 6+ | 2+ |
| 0A | DEC | | 6 | 2 | 3A | ABX | - | 3 | 1 | 6A | DEC | i | 6+ | 2+ |
| OB | • | | U | 2 | 3B | RTI | į | 6/15 | 1 | 6B | • | 1 | • | _ |
| OC | INC | | 6 | 2 | 3C | CWAI | ĺ | ≥ 20 | 2 | 6C | INC | 1 | 6+ | 2+ |
| 0D | TST | | 6 | 2 | 3D | MUL | 1 | 11 | 1 | 6D | TST | | 6+ | 2+ |
| 0E | JMP | 1. | 3 | 2 | 3E | * | T | | | 6E | JMP | Ţ | 3+ | 2+ |
| 0F | CLR | Durant | о 6 | 2 | 3F | SWI | ▼ Inherent | 19 | 1 | 6F | CLR | ▼ Indexed | 6+ | 2+ |
| UF | CLH | Direct | О | 2 | 31 | 3001 | minerent | 13 | , | O1 | CLIT | iiidexed | 0+ | 2+ |
| 10 | Page 2 | | _ | _ | 40 | NEGA | Inherent | 2 | 1 | 70 | NEG | Extended | 7 | 3 |
| 11 | Page 3 | | _ | _ | 41 | • | A | _ | | 71 | • | A | | - |
| 12 | NOP | Inherent | 2 | 1 | 42 | • | T. | | | 72 | • | T | | |
| 13 | SYNC | Inherent | | 1 | 43 | COMA | 1 | 2 | 1 | 73 | COM | 1 | 7 | 3 |
| 14 | • | micrem | = 7 | ' | 44 | LSRA | 1 | 2 | 1 | 74 | LSR | i | 7 | 3 |
| 15 | | | | | 45 | • | 1 | - | | 75 | • | | , | J |
| 16 | LBRA | Relative | _ | 3 | 46 | RORA | | 2 | ì | 76 | ROR | | 7 | 3 |
| 17 | LBSR | | | 3 | 47 | ASRA | | 2 | 1 | 77 | ASR | 1 | 7 | 3 |
| 18 | LBSN | Relative | 9 | 3 | 48 | ASLA, LSLA | | 2 | 1 | 78 | ASL, LSL | 1 | 7 | 3 |
| | D 4 4 | 1-1 | 2 | | 49 | | 1 | 2 | 1 | 79 | ROL | 1 | 7 | 3 |
| 19 | DAA | Inherent | | 1 | | ROLA DECA | | 2 | 1 | 79 7A | DEC | 1 | 7 | 3 |
| 1A | ORCC | Immed | 3 | 2 | 4A | DECA | | 2 | , | 7B | • | | / | 3 |
| 1B | | | | | 4B | 11104 | | • | 1 | 7C | | i | 7 | 3 |
| 1C | ANDCC | Immed | 3 | 2 | 4C | INCA | | 2 | 1 | 7D | INC | | 7 | 3 |
| 1D | SEX | Inherent | | 1 | 4D | TSTA | 1 | 2 | 1 | | TST | 1 | 4 | |
| 1E | EXG | ₽ | 8 | 2 | 4E | | ♥ | | | 7E | JMP | _ \ \ | | 3 |
| 1F | TFR | Inherent | 6 | 2 | 4F | CLRA | Inherent | 2 | 1 | 7F | CLR | Extended | / | 3 |
| 20 | BRA | Relative | 3 | 2 | 50 | NEGB | Inherent | 2 | 1 | 80 | SUBA | Immed | 2 | 2 |
| 21 | BRN | A | 3 | 2 | 51 | • | A | | | 81 | CMPA | A | 2 | 2 |
| 22 | ВНІ | T | 3 | 2 | 52 | • | | | | 82 | SBCA | | 2 | 2 |
| 23 | BLS | ŀ | 3 | 2 | 53 | COMB | į. | 2 | 1 | 83 | SUBD | | 4 | 3 |
| 24 | BHS, BCC | | 3 | 2 | 54 | LSRB | | 2 | 1 | 84 | ANDA | 1 | 2 | 2 |
| 25 | BLO, BCS | | 3 | 2 | 55 | • | 1 | _ | | 85 | BITA | 1 | 2 | 2 |
| 26 | BNE BOS | | 3 | 2 | 56 | RORB | | 2 | 1 | 86 | LDA | | 2 | 2 |
| 27 | BEQ | | 3 | 2 | 57 | ASRB | | 2 | 1 | 87 | • | 1 | - | - |
| 28 | BVC | ì | 3 | 2 | 58 | ASLB, LSLB | 1 | 2 | 1 | 88 | EORA | | 2 | 2 |
| 29 | BVS | 1 | 3 | 2 | 59 | ROLB | I | 2 | i | 89 | ADCA | 1 | 2 | 2 |
| 29 2A | BPL | | 3 | 2 | 5A | DECB | l | 2 | 1 | 8A | ORA | - 1 | 2 | 2 |
| | | 1 | 3 | 2 | 5A 5B | • • | 1 | 2 | ' | 8B | ADDA | 1 | 2 | 2 |
| 2B | BMI | | 3 | | 5B 5C | INCB | 1 | 2 | 1 | 8C | CMPX | ₩ Imms = | 4 | 3 |
| 2C | BGE | | - | 2 | | | 1 | 2 | 1 . | | | Immed | | |
| 2D | BLT | | 3 | 2 | 5D | TSTB • | 1 | 2 | 1 | 8D | BSR | | 7 | 2 |
| 2E | BGT | 2.♥ | 3 | 2 | 5E | CLDD | 1 ■ Y = 1 · · | 2 | 1 | 8E | LDX | Immed | 3 | 3 |
| 2F | BLE | Relative | 3 | 2 | 5F | CLRB | Inherent | 2 | 1 | 8F | | A | | |

LEGEND

- ~ Number of MPU cycles (less possible push pull or indexed-mode cycles)
- # Number of program bytes
- * Denotes unused opcode

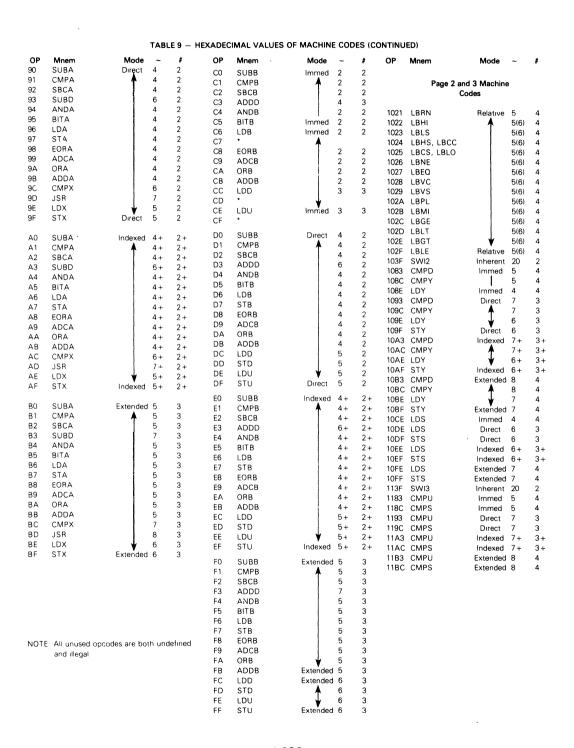


FIGURE 21 — PROGRAMMING AID

| ADCB C9 2 2 0 98 4 2 18 4 2 18 98 5 3 | | | | | | | | | | | = 21 | | | | | | | _ | | | _ | , , | |
|--|-------------|---------|--|------|-----|----------|--------|---|----------|-----|------|----------|------|-------|----|------|----------|--------------------------------|----|-----|-----|-----|-------|
| Mathematical Math | | | lm | medi | ate | | Direct | | | | | | tend | lad . | 1. | here | nt | | | 1 | , | ١, | ١ |
| ADC ADCA ADCA ADCA ADCA ADCA ADCA ADCA | Instruction | Forms | | _ | _ | | | | | | | | | | | | | Description | | | | v | |
| ADD ADD AB ADD AB ADD AB ADD ADD AB ADD ADD | ABX | | Г | | | | | | | | | | | | 3A | 3 | 1 | B + X → X (Unsigned) | • | • | • | • | • |
| ADDB C3 4 2 2 08 4 2 2 68 4 2 68 6 2 3 6 2 3 6 2 3 6 4 2 6 8 | ADC | | | | | | | | | | | | | | | | | | | | | | |
| ADDD C3 | ADD | ADDA | 8B | 2 | 2 | 9B | 4 | 2 | AB | 4+ | | ВВ | 5 | 3 | | | | | + | - | - | 1 | 1 |
| ANDA | | | | | | | | | | | | | | | | l | | | | | | 1 | 1 |
| ANDB Cd 2 2 2 D4 4 2 2 64 4 2 * 64 5 3 | AND | | 1 | 1 | L | | | | | 1. | | | | | L | | _ | | _ | - | | | |
| ASLA ASLB ASLB ASLB ASLB ASLB ASLB ASLB | AND | ANDB | C4 | 2 | 2 | | | | | | | | | | | | | B∧M→B | | | | | • |
| ASRB ASRB ASRB O7 6 2 67 6+ 2+ 77 7 3 3 57 2 1 1 | | ASLB | | | | 08 | 6 | 2 | 68 | 6+ | 2+ | 78 | 7 | 3 | | | | | 8 | 1 | t | 1 | 1 |
| CLR CLR CLR CLR CLR CLR CLR CLR CLR CLR | ASR | ASRB | | | | 07 | 6 | 2 | 67 | 6+ | 2+ | 77 | 7 | 3 | | | | | 8 | 1 | 1 | • | 1 |
| CLRB CMPA 81 2 2 2 91 4 2 2 81 4 2 81 5 3 3 6 8 2 2 6 91 4 2 2 81 4 92 81 6 9 3 3 4 9 2 81 8 4 9 8 9 8 9 8 9 8 9 8 9 8 9 8 9 8 9 8 | BIT | | | | | | | | | | | | | | | | | | | | | | |
| CLR CMPA CMPA CMPA CMPB CH CMPB CMPB CH CMPB CMPB CMPB CMPB CMPB CMPB CMPB CMPB | CLR | | | | | | | | | | | | | | | | | | • | | | | |
| CMPB | | | | | | 0F | 6 | | 6F | 6+ | 2+ | 7F | 7 | 3 | 5F | 2 | 1 | | : | | | | |
| CMPD 83 | CMP | | | | | | | | | | | | | | | | | | | ι. | | | 1 . 1 |
| CMPS 81 | | | | | | | | | | | | | | | | | | | | | | | 1 1 |
| CMPU | | Civii D | |] " | " | | l ' | ٦ | | 1 | 3+ | | 0 | , | | | | Compare IVI IVI + 1 Holl I D | 1 | Ι, | ١, | | ١٠١ |
| CMPV 83 93 9C 6 2 AC 6 + 2 + BC 7 3 BC 7 | | CMPS | | 5 | 4 | | 7 | 3 | | 7+ | 3+ | | 8 | 4 | | | | Compare M M + 1 from S | • | 1 | 1 | 1 | |
| CMMY NOT NOT NOT NOT NOT NOT NOT NOT NOT NOT | | СМРИ | 11 | 5 | 4 | 11 | 7 | 3 | 11 | 7 + | 3. | 11 | 8 | 4 | | | | Compare M M + 1 from U | • | 1 | 1 | 1 | 1 |
| COMB COM COM COM COM COM COM COM COM COM COM | | | 8C 10 | | | 9C 10 | | | AC 10 | 1 . | | BC 10 | ' | | | | | | : | | | | |
| COM CWAI 3C 20 2 3 6 2 63 64 2 73 7 3 | СОМ | | | | | | | | | | | | | | | | | | | | | | |
| DAA DEC DECA DECA DECB DECB DEC DEC DEC DEC DEC D | | сом | | | | 03 | 6 | 2 | 63 | 6+ | 2+ | 73 | 7 | 3 | | | | M→M | • | | | | [1] |
| DEC DECA DECB DEC | | | 3C | ≥20 | 2 | | | | | | | | | | | | | CC ∧ IMM→CC Wait for Interrupt | Г | | | | 7 |
| DECB DEC | | | | | | | | | | | | | | | | | 1 | L | · | 1 | 1 | 0 | 1 |
| EOR EORA | DEC | DECB | | | | | | | | | | | _ | | | | | B – 1 → B | • | 1 | ı | 1 | • |
| EORB C8 2 2 D8 4 2 E8 4+ 2+ F8 5 3 B → M−B | 50B | | 00 | _ | | | | | | L | | L | | | | | - | | 1 | | - | | Ľ |
| NC | EUN | | | | | | | | | | | | | | | | | | | | | | |
| INCB INCC INCC OC 6 2 6C 6+ 2+ 7C 7 3 5C 2 1 B+1-B M+1-M M+1-M M+1 I 1 1 1 1 1 1 1 1 | EXG | R1, R2 | | | | | | | | | | | | | 1E | 8 | 2 | R1 → R2 ² | • | • | • | • | • |
| INC | INC | | | | | | | | | | | | | | | | 1 . | | | | | | • |
| JMP OE 3 2 6E 3+ 2+ 7E 4 3 EA³-PC • | | | | | | l oc | ĥ | 2 | 6C | 6+ | 2+ | 70 | 7 | 3 | 5C | 2 | 1 | | 1 | | | 1 . | |
| JSR | JMP | 1 | | Т | | | | | | + | - | | | - | | - | ┢ | | + | + | - | · | - |
| LDB C6 2 2 D6 4 2 E6 4+ 2+ F6 5 3 | JSR | | T - | Τ. | | 9D | 7 | | AD | 7+ | | | 8 | | _ | | \vdash | Jump to Subroutine | • | • | • | • | • |
| LDD | LD | | | | | | | | | | | | | | | | T | M-A | • | 1 | 1 | | • |
| LDS | | | | | | | | | | | | | | | | | | | 1 | | | | • |
| LDU CE 3 3 3 DE 5 2 EE 5+ 2+ FE 6 3 M M H 1-U M H 1 O 0 L I I O 0 L I I O 0 L I I O 0 L I I O 0 L I I O 0 L I I O 0 L I I O 0 L I I O 0 L I I O 0 L I I I I O 0 L I I I I O 0 L I I I I O 0 L I I I I O 0 L I I I I O 0 L I I I I O 0 L I I I I O 0 L I I I I I I I I I I I I I I I I I I | | | 10 | | | 10 | | | 10 | | | 10 | | | | | | | : | | | | |
| LDX 8E 3 3 9E 5 2 AE 5+ 2+ BE 6 3 M M + 1- X M M + 1- X M M + 1- Y LEA LEAS LEAU LEAX LEAX LEAX SHARL | | LDII | | 12 | 1 | | 5 | 2 | | 5. | 12. | | | 1 | | | | NA NA . 1 . 11 | 1. | | ١. | | |
| LDY 10 4 4 10 6 3 10 6+ 3+ 10 7 4 MM+1-Y | | | | | | | | | | | | | | | | | 1 | | 1 | | | | |
| LEA LEAS | | | 10 | | | 10 | | | 10 | | | 10 | | | | | | | • | | 1 | | • |
| $\begin{bmatrix} LEAX & 1 & 1 & 1 & 30 & 4+1 & 2+1 & 1 & 1 & 1 & EA^3 \to X & 1 & 0 & 0 & 1 & 0 & 0 & 0 & 0 & 0 & 0$ | LEA | | | | | | | | 32 | | | | | T | | | | | • | | 1 | 1 | • |
| LEAY | | | | | | | | | | | | | | | | | | | : | 1 | 1 - | 1 | 1 1 |
| | | | | | | | | | | | | | | | | | | EA3-Y | | l l | | | • |

Legend

- Number of MPU Cycles H Half-carry (from bit 3)
- Number of Program Bytes
- Arithmetic Plus
- Arithmetic Minus Multiply
- OP Operation Code (Hexadecimal)
- M Complement of M
- → Transfer Into
- N Negative (sign bit)
 - Z Zero result
 - V Overflow, 2's complement
 - C Carry from ALU

- Test and set if true, cleared otherwise t
- Not Affected
- CC Condition Code Register
 - Concatenation
- V Logical or
- Λ Logical and
- → Logical Exclusive or

FIGURE 21 - PROGRAMMING AID (CONTINUED)

| | | | | | | | Ad | dressi | ing N | Aodes | | | | | | | | T | | | | Г |
|-------------|--------------------------------------|----------------|-------------|-------|----------------------------|-----------|------------------|----------------------------------|----------------------|----------------------|----------------------------------|------------------|------------------|----------------|----------|-----|--|-------------|---|---------|-------------|-----|
| | | In | media | te | | Direc | | | ndexe | | E | tend | ed | li | nhere | nt | | 5 | 3 | 2 | 1 | 0 |
| Instruction | Forms | Op | - | 1 | Op | ~ | - | Op | 7- | 1 | Op | ~ | # | Op | ~ | * | Description | H | N | Z | V | C |
| LSL | LSLA LSLB LSL | | | | 08 | 6 | 2 | 68 | 6+ | 2+ | 78 | 7 | 3 | 48 58 | 2 2 | 1 | A B C b7 b0 | : | 1 : : | 1 1 | | : |
| LSR | LSRA LSRB LSR | | | | 04 | 6 | 2 | 64 | 6+ | 2+ | 74 | 7 | 3 | 44 54 | 2 2 | 1 | Å 0 → 1 → 1 → 1 c | : | 000 | 1 1 | : | 1 1 |
| MUL | | | | | | | | | | | | | | 3D | 11 | 1 | A × B → D (Unsigned) | | • | 1 | • | 9 |
| NEG | NEGA NEGB NEG | | | | 00 | 6 | 2 | 60 | 6+ | 2+ | 70 | 7 | 3 | 40 50 | 2 | 1 | A + 1 - A B + 1 - B M + 1 - M | 8 8 8 | | 1 1 1 | | 1 1 |
| NOP | | | | | | | | | | | | | | 12 | 2 | 1 | No Operation | • | • | • | • | • |
| OR | ORA ORB ORCC | 8A CA 1A | 2 2 3 | 2 2 2 | 9A DA | 4 | 2 2 | AA EA | 4+4+ | 2+ 2+ | BA FA | 5 5 | 3 | | | | A V M - A B V M - B CC V IMM - CC | : | 1 1 | 1 | 0 0 7 | : |
| PSH | PSHS PSHU | 34 36 | 5+4 5+4 | 2 2 | | | | | | | | | | | | | Push Registers on S Stack Push Registers on U Stack | : | : | : | : | • |
| PUL | PULS PULU | 35 37 | 5+4 5+4 | 2 2 | | | | | | | | | | | | | Pull Registers from S Stack Pull Registers from U Stack | : | : | • | : | : |
| ROL | ROLA ROLB ROL | | | | 09 | 6 | 2 | 69 | 6+ | 2+ | 79 | 7 | 3 | 49 59 | 2 | 1 | B | | 1 1 | 1 | 1 1 | 1 1 |
| ROR | RORA RORB ROR | | | | 06 | 6 | 2 | 66 | 6+ | 2+ | 76 | 7 | 3 | 46 56 | 2 | 1 | A B B C D D D D D D D D D D D D D D D D D | | 1 1 1 | 1 | : | 1 1 |
| RTI | | | | | | | | | | | | | | 3B | 6/15 | 1 | Return From Interrupt | Γ | Г | | | 7 |
| RTS | | | | | | | | | | | | | | 39 | 5 | 1 | Return from Subroutine | • | • | • | • | • |
| SBC | SBCA SBCB | 82 C2 | 2 | 2 2 | 92 D2 | 4 | 2 | A2 E2 | 4 + 4 + | 2+ 2+ | B2 F2 | 5 5 | 3 3 | | | | A - M - C - A B - M - C - B | 8 | 1 | 1 | 1 | :: |
| SEX | | | | | | | | | | | | | | 1D | 2 | 1 | Sign Extend B into A | • | 1 | 1 | 0 | • |
| ST | STA STB STD STS | | | | 97 D7 DD 10 DF | 4 4 5 6 5 | 2 2 2 3 | A7 E7 ED 10 EF EF | 4+ 4+ 5+ 6+ | 2+ 2+ 2+ 3+ | B7 F7 FD 10 FF FF | 5 5 7 6 | 3 3 4 4 | | | | A-M B-M D-M M+1 S-M M+1 | | 1 | 1 1 1 1 | 0000 | |
| | STX STY | | | | 9F 10 9F | 5 6 | 3 | AF 10 AF | 5+ 6+ | 2+ 3+ | BF 10 BF | 6 7 | 3 | | | | X M M + 1 Y M M + 1 | : | 1 | 1 | 0 | • |
| SUB | SUBA SUBB SUBD | 80 C0 83 | 2 2 4 | 2 2 3 | 90 D0 93 | 4 6 | 2 2 2 | A0 E0 A3 | 4+ 4+ 6+ | 2+ 2+ 2+ | B0 F0 B3 | 5 5 7 | 3 3 3 | | | | A − M → A B − M → B D − M M + 1 → D | 8 | 1 1 | 1 1 | 1 1 | 1 1 |
| SWI | SWI ⁶ SWI ⁶ | | | | | | | | | | | | | 3F 10 3F | 19 20 | 1 2 | Software Interrupt 1 Software Interrupt 2 | : | : | • | : | : |
| | swi ⁶ | | | | | | | | | | | | | 11 3F | 20 | 1 | Software Interrupt 3 | • | • | • | • | • |
| SYNC | | | | | | | | | | | | | | 13 | ≥4 | 1 | Synchronize to Interrupt | • | • | • | • | • |
| TFR | R1, R2 | | | | | | | | | | | | | 1F | 6 | 2 | R1 → R2 ² | • | • | • | • | • |
| TST | TSTA TSTB TST | | | | 0D | 6 | 2 | 6D | 6+ | 2+ | 7D | 7 | 3 | 4D 5D | 2 2 | 1 | Test A Test B Test M | : | 1 1 1 | 1 | 0 0 | : |

Notes

- 1 This column gives a base cycle and byte count. To obtain total count, add the values obtained from the INDEXED ADDRESSING MODE table, Table 2
- 2 R1 and R2 may be any pair of 8 bit or any pair of 16 bit registers. The 8 bit registers are A, B, CC, DP

The 16 bit registers are X, Y, U, S, D, PC

- 3 EA is the effective address
- 4 The PSH and PUL instructions require 5 cycles plus 1 cycle for each **byte** pushed or pulled
- 5 5(6) means 5 cycles if branch not taken, 6 cycles if taken (Branch instructions)
- 6 SWI sets I and F bits SWI2 and SWI3 do not affect I and F
- 7 Conditions Codes set as a direct result of the instruction
- 8 Vaue of half-carry flag is undefined
- 9 Special Case Carry set if b7 is SET

FIGURE 21 - PROGRAMMING AID (CONCLUDED)

Branch Instructions

| | | Addressing Mode Relative | | | | 5 | 3 | 2 | 1 | 0 |
|-------------|-------------|--------------------------------|-----------|--------|---|---|-----|-----|-----|-----|
| Instruction | Forms | OP | ~9 | | Description | H | N | Z | v | Ċ |
| BCC | BCC LBCC | 24 10 24 | 3 5(6) | 2 4 | Branch C=0 Long Branch C=0 | : | • | • | • | : |
| BCS | BCS LBCS | 25 10 25 | 3 5(6) | 4 | Branch C=1 Long Branch C=1 | : | • | • | • | • |
| BEQ | BEQ LBEQ | 27 10 27 | 3 5(6) | 4 | Branch Z= 1 Long Branch Z=0 | : | • | • | • | : |
| BGE | BGE LBGE | 2C 10 2C | 3 5(6) | 2 4 | Branch≥Zero Long Branch≥Zero | : | • | • | • | • |
| BGT | BGT LBGT | 2E 10 2E | 3 5(6) | 2 | Branch > Zero Long Branch > Zero | : | • | • | • | : |
| ВНІ | BHI LBHI | 22 10 22 | 3 5(6) | 2 4 | Branch Higher Long Branch Higher | : | • • | • | • • | : |
| BHS | BHS | 24 10 24 | 3 5(6) | 4 | Branch Higher or Same Long Branch Higher or Same | | • | • | • | • |
| BLE | BLE LBLE | 2F 10 2F | 3 5(6) | 2 4 | Branch≤Zero Long Branch≤Zero | : | : | • • | •• | • • |
| BLO | BLO LBLO | 25 10 25 | 3 5(6) | 4 | Branch lower Long Branch Lower | • | • | • | • | • |

| | | | dress Mode | | | 5 | 3 | 2 | 1 | 0 |
|-------------|-------------|----------------------|---------------|--------|--|---|---|---|---|---|
| Instruction | Forms | OP | ~ | # | Description | H | N | Z | V | C |
| BLS | BLS LBLS | 23 10 | 3 5(6) | 2 | Branch Lower or Same Long Branch Lower | | • | | • | • |
| BLT | BLT LBLT | 23 2D 10 2D | 3 5(6) | 2 | or Same Branch < Zero Long Branch < Zero | : | : | : | : | : |
| ВМІ | BMI LBMI | 2B 10 2B | 3 5(6) | 2 4 | Branch Minus Long Branch Minus | • | : | : | : | : |
| BNE | BNE LBNE | 26 10 26 | 3 5(6) | 2 4 | Branch Z=0 Long Branch Z≠0 | : | : | : | : | : |
| BPL | BPL LBPL | 2A 10 2A | 3 5(6) | 2 4 | Branch Plus Long Branch Plus | • | : | • | : | : |
| BRA | BRA LBRA | 20 16 | 3 5 | 2 | Branch Always Long Branch Always | : | : | : | : | : |
| BRN | BRN LBRN | 21 10 21 | 3 5 | 4 | Branch Never Long Branch Never | : | : | : | : | : |
| BSR | BSR LBSR | 8D 17 | 7 9 | 3 | Branch to Subroutine Long Branch to Subroutine | : | : | : | : | • |
| BVC | BVC LBVC | 28 10 28 | 3 5(6) | 2 4 | Branch V = 0 Long Branch V = 0 | • | : | : | : | : |
| BVS | BVS LBVS | 29 10 29 | 3 5(6) | 2 4 | Branch V = 1 Long Branch V = 1 | : | • | : | : | • |

SIMPLE BRANCHES

| | OP | ~_ | # |
|------|------|----|---|
| BRA | 20 | 3 | 2 |
| LBRA | 16 | 5 | 3 |
| BRN | 21 | 3 | 2 |
| LBRN | 1021 | 5 | 4 |
| BSR | 8D | 7 | 2 |
| LBSR | 17 | 9 | 3 |

| SIMPLE CO | ONDITIONA | L BRANC | HES (Note | s 1-4) |
|-----------|-----------|---------|-----------|--------|
| Test | True | OP | False | OP |
| N = 1 | BMI | 2B | BPL | 2A |
| | | | | |

| Test | True | OP | False | OP |
|-------|------|----|-------|----|
| N = 1 | BMI | 2B | BPL | 2A |
| Z = 1 | BEQ | 27 | BNE | 26 |
| V = 1 | BVS | 29 | BVC | 28 |
| C = 1 | BCS | 25 | BCC | 24 |
| | | | | |

SIGNED CONDITIONAL BRANCHES (Notes 1-4)

| Test | True | OP | False | OP |
|-------|------|----|-------|----|
| r>m | BGT | 2E | BLE | 2F |
| r≥m | BGE | 2C | BLT | 2D |
| r = m | BEQ | 27 | BNE | 26 |
| r≤m | BLE | 2F | BGT | 2E |
| r < m | BLT | 2D | BGE | 2C |

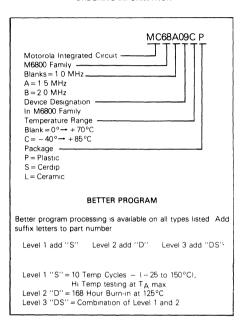
UNSIGNED CONDITIONAL BRANCHES (Notes 1-4)

| Test | True | OP | False | OP_ |
|-------|------|----|-------|-----|
| r>m | BHI | 22 | BLS | 23 |
| r≥m | BHS | 24 | BLO | 25 |
| r = m | BEQ | 27 | BNE | 26 |
| r≤m | BLS | 23 | BHI | 22 |
| r < m | BLO | 25 | BHS | 24 |

Notes

- 1 All conditional branches have both short and long variations
- 2 All short branches are 2 bytes and require 3 cycles
- 3 All conditional long branches are formed by prefixing the short branch opcode with \$10 and using a 16-bit destination offset
- 4 All conditional long branches require 4 bytes and 6 cycles if the branch is taken or 5 cycles if the branch is not taken

ORDERING INFORMATION





MC6809E MC68A09E **MC68B09E** (2.0 MHz)

8-BIT MICROPROCESSING UNIT

The MC6809E is a revolutionary high performance 8-bit microprocessor which supports modern programming techniques such as position independence, reentrancy, and modular programming.

This third-generation addition to the M6800 family has major architectural improvements which include additional registers, instructions and addressing modes.

The basic instructions of any computer are greatly enhanced by the presence of powerful addressing modes. The MC6809E has the most complete set of addressing modes available on any 8-bit microprocessor today.

The MC6809E has hardware and software features which make it an ideal processor for higher level language execution or standard controller applications. External clock inputs are provided to allow synchronization with peripherals, systems or other MPUs.

MC6800 COMPATIBLE

- Hardware Interfaces with All M6800 Peripherals
 Software Upward Source Code Compatible Instruction Set and Addressing Modes

ARCHITECTURAL FEATURES

- Two 16-bit Index Registers
- Two 16-bit Indexable Stack Pointers
- Two 8-bit Accumulators can be Concatenated to Form One 16-Bit
- Accumulator Direct Page Register Allows Direct Addressing Throughout Memory

HARDWARE FEATURES

- External Clock Inputs, E and Q, Allow Synchronization
- TSC Input Controls Internal Bus Buffers
- LIC Indicates Opcode Fetch
- AVMA Allows Efficient Use of Common Resources in A Multiprocessor System
- BUSY is a Status Line for Multiprocessing
- Fast Interrupt Request Input Stacks Only Condition Code Register and Program Counter
- Interrupt Acknowledge Output Allows Vectoring By Devices
- SYNC Acknowledge Output Allows for Synchronization to External Event
- Single Bus-Cycle RESET
- Single 5-Volt Supply Operation
- NMI Inhibited After RESET Until After First Load of Stack Pointer
- Early Address Valid Allows Use With Slower Memories
- Early Write-Data for Dynamic Memories

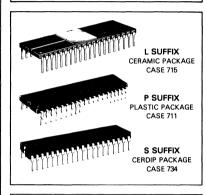
SOFTWARE FEATURES

- 10 Addressing Modes
 - M6800 Upward Compatible Addressing Modes
 - Direct Addressing Anywhere in Memory Map
 - Long Relative Branches
 - Program Counter Relative
 - True Indirect Addressing
 - Expanded Indexed Addressing:
 - 0, 5, 8, or 16-bit Constant Offsets
 - 8, or 16-bit Accumulator Offsets
 - Auto-Increment/Decrement by 1 or 2
- Improved Stack Manipulation
- 1464 Instructions with Unique Addressing Modes
- 8 × 8 Unsigned Multiply
- 16-bit Arithmetic
- Transfer/Exchange All Registers
- Push/Pull Any Registers or Any Set of Registers
- Load Effective Address

HMOS

(HIGH-DENSITY N-CHANNEL, SILICON-GATE)

8-BIT MICROPROCESSING UNIT



| FIGU | RE 1 — PIN ASSIG | SNN | MENT |
|--------------------------|------------------|-----|---------------|
| v _{ss} t | | 40 | HALT |
| NMI [| 2 | 39 | тѕс |
| ĪR O [| 3 | 38 | LIC |
| FIRO | 4 | 37 | RESET |
| BS□ | 5 | 36 | AVMA |
| ВА [| 6 | 35 | DΩ |
| v _{cc} t | 7 | 34 |]E |
| A0 [| 8 | 33 | BUSY |
| A1' [| 9 | 32 | n R/₩ |
| A2 [| 10 | 31 | 1 D0 |
| A3 [| 11 | 30 | 1 D1 |
| A4 [| 12 | 29 | J D2 |
| A5 [| 13 | 28 | D D3 |
| A6 [| 14 | 27 | 1 D4 |
| A7 [| | 26 |] D5 |
| A8 [| 16 | 25 | ⊒ ID6 |
| A9 [| 17 | 24 | 1 D7 |
| A10 [| 18 | 23 | 1 A15 |
| A11 [| 19 | 22 | 1 A14 |
| A12 [| 20 | 21 | 1 A13 |
| ' | | | • |

MAXIMUM RATINGS

| Rating | Symbol | Value | Unit |
|--|------------------|--|------|
| Supply Voltage | Vcc | -03 to +70 | ٧ |
| Input Voltage | V _{in} | -03 to +70 | ٧ |
| Operating Temperature Range MC6809E, MC68A09E, MC68B09E | ТА | T _L to T _H 0 to +70 | °C |
| Storage Temperature Range | T _{stq} | -55 to +150 | °C |

This device contains circuitry to protect the inputs against damage due to high static voltages or electric fields, however, it is advised that normal precautions be taken to avoid application of any voltage higher than maximum rated voltages to this high impedance circuit.

Reliability of operation is enhanced if unused inputs are tied to an appropriate logic voltage level (e.g., either VSS or VCC).

(2)

THERMAL CHARACTERISTICS

| Characteristic | Symbol | Value | Unit |
|--------------------|---------------|-------|------|
| Thermal Resistance | | | |
| Ceramic | İ | 50 | ł |
| Cerdip | θ_{JA} | 60 | °C/W |
| Plastic | 1 | 100 | } |

POWER CONSIDERATIONS

The average chip-junction temperature, TJ, in °C can be obtained from

$$T_{J} = T_{A} + (P_{D} \bullet \theta_{JA})$$
Where

T_Δ = Ambient Temperature, °C

θ JA ≡ Package Thermal Resistance, Junction-to-Ambient, °C/W

PD = PINT + PPORT

PINT = ICC × VCC, Watts - Chip Internal Power

PPORT = Port Power Dissipation, Watts - User Determined

For most applications PPORT ◆PINT and can be neglected. PPORT may become significant if the device is configured to drive Darlington bases or sink LED loads.

An approximate relationship between PD and TJ (if PPORT is neglected) is:

$$P_D = K - (T_1 + 273 ^{\circ}C)$$

Solving equations 1 and 2 for K gives.

$$K = P_D \bullet (T_\Delta + 273 \, ^{\circ}\text{C}) + \theta_J \Delta \bullet P_D^2$$
(3)

Where K is a constant pertaining to the particular part. K can be determined from equation 3 by measuring PD (at equilibrium) for a known T_A . Using this value of K the values of PD and T_J can be obtained by solving equations (1) and (2) iteratively for any value of T_A .

DC ELECTRICAL CHARACTERISTICS ($V_{CC} = 5.0 \text{ V } \pm 5\%$, $V_{SS} = 0$, $T_A = T_L$ to T_H unless otherwise noted)

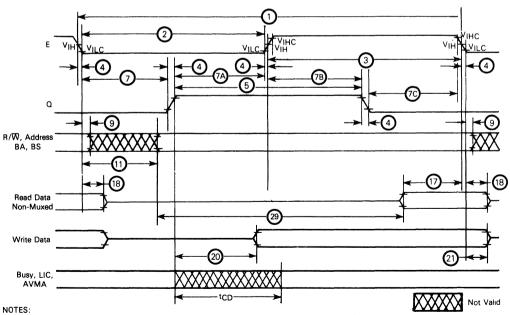
| Characteristic | | Symbol | Min | Тур | Max | Unit |
|---|---|--------------------------------------|--|--------------|--|------|
| Input High Voltage | Logic, Q, RESET E | VIH VIHR VIHC | V _{SS} + 20 V _{SS} + 40 V _{CC} -075 | _ | V _{CC} +03 | ٧ |
| Input Low Voltage | Logic, Q, RESET E | V _{IL} V _{IL} C | V _{SS} - 03 V _{SS} -03 | = | V _{SS} + 08 V _{SS} +0.4 | ٧ |
| Input Leakage Current (V _{In} = 0 to 5 25 V, V _{CC} = max) | Logic, Q, RESET E | l _{in} | _ | - | 2.5 100 | μΑ |
| DC Output High Voltage (ILoad = $-205 \mu\text{A}$, VCC = min) (ILoad = $-145 \mu\text{A}$, VCC = min) (ILoad = $-140 \mu\text{A}$, VCC = min) | D0-D7 A0-A15, R/ W BA, BS, LIC, AVMA, BUSY | Vон | V _{SS} + 24 V _{SS} + 24 V _{SS} + 24 | - - - | - - - | ٧ |
| DC Output Low Voltage (I _{Load} = 2 0 mA, V _{CC} = min) | | VOL | - | - | V _{SS} + 05 | ٧ |
| Internal Power Dissipation (Measured at TA= | T _L in Steady State Operation) | PINT | _ | - | 1.0 | W |
| Capacitance* $(V_{IN} = 0, 1_A = 25^{\circ}C, f = 1.0 \text{ MHz})$ | D0-D7, Logic Inputs, Q, RESET | C _{in} | _ | 10 30 | 15 50 | pF |
| | A0-A15, R/W, BA, BS LIC, AVMA, BUSY | Cout | - | 10 | 15 | pF |
| Frequency of Operation (E and Q Inputs) | MC6809E MC68A09E MC68B09E | f | 0 1 0 1 0 1 | - - | 1.0 1.5 2.0 | MHz |
| Three-State (Off State) Input Current (V _{In} = 0 4 to 2 4 V, V _{CC} = max) | D0-D7 A0-A15, R/W | ^I TSI | - | 2 0 - | 10 100 | μΑ |

^{*}Capacitances are periodically tested rather than 100% tested

BUS TIMING CHARACTERISTICS (See Notes 1, 2, 3, and 4)

| ldent. | | | MC6809E | | MC68A09E | | MC68B09E | | Unit |
|--------|---|---------------------------------|---------|------|----------|------|----------|------|------|
| Number | Characteristics | Symbol | Min | Max | Min | Max | Min | Max | Unit |
| 1 | Cycle Time | tcyc | 10 | 10 | 0 667 | 10 | 05 | 10 | μS |
| 2 | Pulse Width, E Low | PWEL | 450 | 9500 | 295 | 9500 | 210 | 9500 | ns |
| 3 | Pulse Width, E High | PWEH | 450 | 9500 | 280 | 9500 | 220 | 9500 | ns |
| 4 | Clock Rise and Fall Time | t _r , t _f | - | 25 | - | 25 | - | 20 | ns |
| 5 | Pulse Width, Q High | PWQH | 450 | 9500 | 280 | 9500 | 220 | 9500 | ns |
| 7 | Delay Time, E to Q Rise | tEQ1 | 200 | - | 130 | | 100 | - | ns |
| 7A | Delay Time, Q High to E Rise | tEQ2 | 200 | - | 130 | | 100 | - | ns |
| 7B | Delay Time, E High to Q Fall | tEQ3 | 200 | - | 130 | - | 100 | - | ns |
| 7C | Delay Time, Q High to E Fall | tEQ4 | 200 | - | 130 | - | 100 | - | ns |
| 9 | Address Hold Time | ^t AH | 20 | - | 20 | - | 20 | - | ns |
| 11 | Address Delay Time from E Low (BA, BS, R/W) | †AD | - | 200 | | 140 | _ | 110 | ns |
| 17 | Read Data Setup Time | †DSR | 80 | - | 60 | _ | 40 | _ | ns |
| 18 | Read Data Hold Time | ^t DHR | 10 | - | 10 | _ | 10 | _ | ns |
| 20 | Data Delay Time from Q | tDDQ | - | 200 | _ | 140 | _ | 110 | ns |
| 21 | Write Data Hold Time | tDHW | 30 | - | 30 | - | 30 | - | ns |
| 29 | Usable Access Time | tACC | 695 | _ | 440 | - | 330 | _ | ns |
| | Control Delay Time (Figure 2) | tCD | - | 300 | _ | 250 | - | 200 | ns |
| | Interrupts, HALT, RESET, and TSC Setup Time (Figures 7, 8, 9, 10, 13, and 14) | [†] PCS | 200 | - | 140 | - | 110 | - | ns |
| | TSC Drive to Valid Logic Level (Figure 14) | tTSV | _ | 210 | _ | 150 | - | 120 | ns |
| | TSC Release MOS Buffers to High Impedance (Figure 14) | tTSR | _ | 200 | - | 140 | - | 110 | ns |
| | TSC Three-State Delay Time (Figure 14) | tTSC | - | 120 | - | 85 | - | 80 | ns |
| | Processor Control Rise and Fall Time (Figure 8) | tPCr, tPCf | - | 100 | - | 100 | _ | 100 | ns |

FIGURE 2 - READ/WRITE DATA TO MEMORY OR PERIPHERALS



1. Voltage levels shown are V_L≤0 4 V, V_{IH}≥2 4 V, unless otherwise specified ¹3 Hold time (⑨) for BA and BS is not specified 2. Measurement points shown are 0.8 V and 2 0 V, unless otherwise specified 4 Usable access time is computed by. 1 – 4 – 11 max – 17

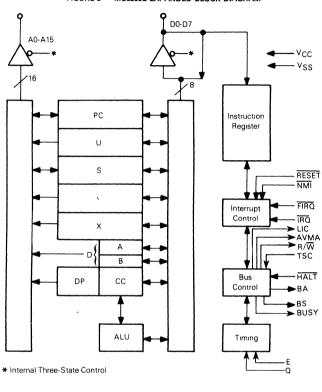
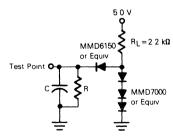


FIGURE 3 - MC6809E EXPANDED BLOCK DIAGRAM

FIGURE 4 - BUS TIMING TEST LOAD



C=30 pF for BA, BS, LIC, AVMA, BUSY 130 pF for D0-D7 90 pF for A0-A15, R/\overline{W}

R = 11.7 k Ω for D0-D7 16.5 k Ω for A0-A15, R/ \overline{W} 24 k Ω for BA, BS LIC, AVMA, BUSY

PROGRAMMING MODEL

As shown in Figure 5, the MC6809E adds three registers to the set available in the MC6800. The added registers include a Direct Page Register, the User Stack pointer and a second Index Register.

ACCUMULATORS (A, B, D)

The A and B registers are general purpose accumulators which are used for arithmetic calculations and manipulation of data.

Certain instructions concatenate the A and B registers to form a single 16-bit accumulator. This is referred to as the D Register, and is formed with the A Register as the most significant byte

DIRECT PAGE REGISTER (DP)

The Direct Page Register of the MC6809E serves to enhance the Direct Addressing Mode. The content of this register appears at the higher address outputs (A8-A15) during direct addressing instruction execution. This allows the direct mode to be used at any place in memory, under program control. To ensure M6800 compatibility, all bits of this register are cleared during Processor Reset.

X - Index Register Y - Index Register Pointer Registers U - User Stack Pointer S - Hardware Stack Pointer PC Program Counter В Accumulators Α n DP Direct Page Register N С Н Ζ CC - Condition Code Register

FIGURE 5 - PROGRAMMING MODEL OF THE MICROPROCESSING UNIT

INDEX REGISTERS (X, Y)

The Index Registers are used in indexed mode of addressing. The 16-bit address in this register takes part in the calculation of effective addresses. This address may be used to point to data directly or may be modifed by an optional constant or register offset. During some indexed modes, the contents of the index register are incremented or decremented to point to the next item of tabular type data. All four pointer register (X, Y, U, S) may be used as index registers.

STACK POINTER (U, S)

The Hardware Stack Pointer (S) is used automatically by the processor during subroutine calls and interrupts. The User Stack Pointer (U) is controlled exclusively by the programmer thus allowing arguments to be passed to and from subroutines with ease. The U-register is frequently used as a stack marker. Both Stack Pointers have the same indexed mode addressing capabilities as the X and Y registers, but also support **Push** and **Pull** instructions. This allows the MC6809E to be used efficiently as a stack processor, greatly enhancing its ability to support higher level languages and modular programming.

NOTE

The stack pointers of the MC6809E point to the top of the stack, in contrast to the MC6800 stack pointer, which pointed to the next free location on stack.

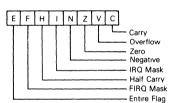
PROGRAM COUNTER

The Program Counter is used by the processor to point to the address of the next instruction to be executed by the processor. Relative Addressing is provided allowing the Program Counter to be used like an index register in some situations.

CONDITION CODE REGISTER

The Condition Code Register defines the state of the processor at any given time See Figure 6

FIGURE 6 - CONDITION CODE REGISTER FORMAT



CONDITION CODE REGISTER DESCRIPTION

BIT 0 (C)

Bit 0 is the carry flag, and is usually the carry from the binary ALU C is also used to represent a 'borrow' from subtract like instructions (CMP, NEG, SUB, SBC) and is the complement of the carry from the binary ALU.

BIT 1 (V)

Bit 1 is the overflow flag, and is set to a one by an operation which causes a signed two's complement arithmetic overflow. This overflow is detected in an operation in which the carry from the MSB in the ALU does not match the carry from the MSB-1.

BIT 2 (Z)

Bit 2 is the zero flag, and is set to a one if the result of the previous operation was identically zero

BIT 3 (N)

Bit 3 is the negative flag, which contains exactly the value of the MSB of the result of the preceding operation. Thus, a negative two's-complement result will leave N set to a one.

BIT 4 (I)

Bit 4 is the \overline{IRQ} mask bit. The processor will not recognize interrupts from the \overline{IRQ} line if this bit is set to a one \overline{NMI} , \overline{FIRQ} , \overline{IRQ} , \overline{RESET} , and SWI all set I to a one, SWI2 and SWI3 do not affect I

BIT 5 (H)

Bit 5 is the half-carry bit, and is used to indicate a carry from bit 3 in the ALU as a result of an 8-bit addition only (ADC or ADD). This bit is used by the DAA instruction to perform a BCD decimal add adjust operation. The state of this flag is undefined in all subtract-like instructions

BIT 6 (F)

Bit 6 is the \overline{FIRO} mask bit. The processor will not recognize interrupts from the \overline{FIRO} line if this bit is a one \overline{NMI} , \overline{FIRO} , SWI, and \overline{RESET} all set F to a one. \overline{IRO} , SWI2 and SWI3 do not affect F.

BIT 7 (E)

Bit 7 is the entire flag, and when set to a one indicates that the complete machine state (all the registers) was stacked, as opposed to the subset state (PC and CC). The E bit of the stacked CC is used on a return from interrupt (RTI) to determine the extent of the unstacking. Therefore, the current E left in the Condition Code Register represents past action.

PIN DESCRIPTIONS

POWER (VSS, VCC)

Two pins are used to supply power to the part' VSS is ground or 0 volts, while VCC is $+50 \text{ V} \pm 5\%$

ADDRESS BUS (A0-A15)

Sixteen pins are used to output address information from the MPU onto the Address Bus. When the processor does not require the bus for a data transfer, it will output address $\frac{\text{FFF1}_{16}}{\text{FF}_{16}}$, $R/\overline{W}=1$, and BS=0, this is a "dummy access" or $\overline{\text{VMA}}$ cycle. All address bus drivers are made high-impedance when output Bus Available (BA) is high or when TSC is asserted. Each pin will drive one Schottky TTL load or four LS TTL loads, and 90 pF

DATA BUS (D0-D7)

These eight pins provide communication with the system bi-directional data bus. Each pin will drive one Schottky TTL load or four LS TTL loads, and 130 pF

READ/WRITE (R/W)

This signal indicates the direction of data transfer on the data bus. A low indicates that the MPU is writing data onto the data bus. R/\overline{W} is made high impedance when BA is high or when TSC is asserted

RESET

A low level on this Schmitt-trigger input for greater than one bus cycle will reset the MPU, as shown in Figure 7. The

Reset vectors are fetched from locations FFFE $_{16}$ and FFFF $_{16}$ (Table 1) when Interrupt Acknowledge is true, $(\overline{BA} \bullet BS = 1)$ During initial power-on, the Reset line should be held low until the clock input signals are fully operational

Because the MC6809E Reset pin has a Schmitt-trigger input with a threshold voltage higher than that of standard peripherals, a simple R/C network may be used to reset the entire system. This higher threshold voltage ensures that all peripherals are out of the reset state before the Processor

HALT

A low level on this input pin will cause the MPU to stop running at the end of the present instruction and remain halted indefinitely without loss of data. When halted, the BA output is driven high indicating the buses are high impedance BS is also high which indicates the processor is in the Halt state. While halted, the MPU will not respond to external real-time requests (FIRQ, IRQ) although $\overline{\text{NMI}}$ or RESET will be latched for later response. During the Halt state Q and E should continue to run normally. A halted state (BA+BS=1) can be achieved by pulling $\overline{\text{HALT}}$ low while RESET is still low. See Figure 8

BUS AVAILABLE, BUS STATUS (BA, BS)

The Bus Available output is an indication of an internal control signal which makes the MOS buses of the MPU high impedance. When BA goes low, a dead cycle will elapse before the MPU acquires the bus. BA will not be asserted when TSC is active, thus allowing dead cycle consistency.

The Bus Status output signal, when decoded with BA, represents the MPU state (valid with leading edge of Q)

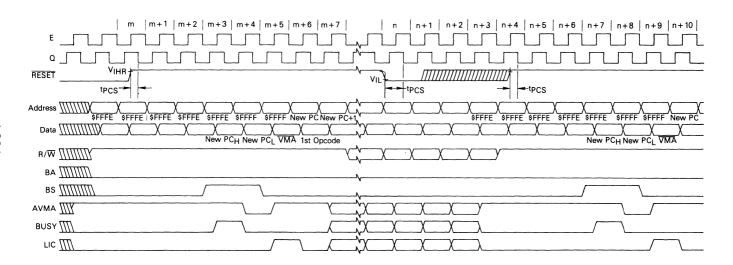
| MPU | State | MPU State Definition | |
|-----|-------|--------------------------------|--|
| BA | BS | Wil o State Delitition | |
| 0 | 0 | Normal (Running) | |
| 0 | 1 | Interrupt or RESET Acknowledge | |
| 1 | 0 | SYNC Acknowledge | |
| 1 | 1 | HALT Acknowledge | |

Interrupt Acknowledge is indicated during both cycles of a hardware-vector-fetch (RESET, NMI, FIRQ, IRQ, SWI, SWI2, SWI3) This signal, plus decoding of the lower four address lines, can provide the user with an indication of which interrupt level is being serviced and allow vectoring by device. See Table 1

TABLE 1 - MEMORY MAP FOR INTERRUPT VECTORS

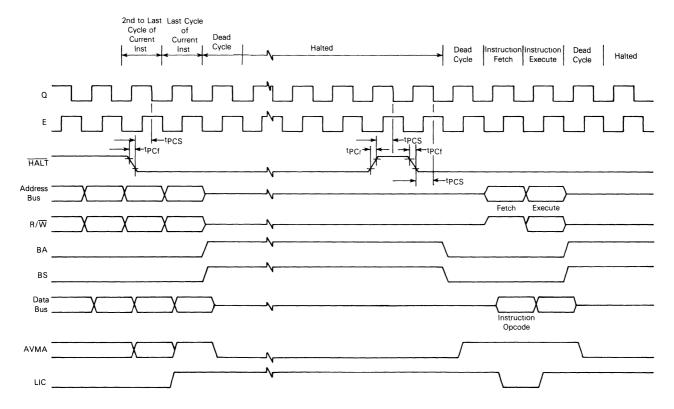
| | Map For ocations | Interrupt Vector |
|------|------------------|------------------|
| MS | LS | Description |
| FFFE | FFFF | RESET |
| FFFC | FFFD | NMI |
| FFFA | FFFB | SWI |
| FFF8 | FFF9 | ĪRQ |
| FFF6 | FFF7 | FIRQ |
| FFF4 | FFF5 | SWI2 |
| FFF2 | FFF3 | SWI3 |
| FFF0 | FFF1 | Reserved |

FIGURE 7 - RESET TIMING



NOTE Timing measurements are referenced to and from a low voltage of 0.8 volts and a high voltage of 2.0 volts, unless otherwise noted

FIGURE 8 - HALT AND SINGLE INSTRUCTION EXECUTION TIMING FOR SYSTEM DEBUG



NOTE Timing measurements are referenced to and from a low voltage of 0.8 volts and a nigh voltage of 2.0 volts, unless otherwise noted

Sync Acknowledge is indicated while the MPU is waiting for external synchronization on an interrupt line.

Halt/Acknowledge is indicated when the MC6809E is in a Halt condition.

NON MASKABLE INTERRUPT (NMI)*

A negative transition on this input requests that a non-maskable interrupt sequence be generated. A non-maskable interrupt cannot be inhibited by the program, and also has higher priority than \overline{FIRQ} , \overline{IRQ} or software interrupts. During recognition of an \overline{NMI} , the entire machine state is saved on the hardware stack. After reset, an \overline{NMI} will not be recognized until the first program load of the Hardware Stack Pointer (S). The pulse width of \overline{NMI} low must be at least one E cycle. If the \overline{NMI} input does not meet the minimum set up with respect to Q, the interrupt will not be recognized until the next cycle. See Figure 9.

FAST-INTERRUPT REQUEST (FIRQ)*

A low level on this input pin will initiate a fast interrupt sequence, provided its mask bit (F) in the CC is clear. This sequence has priority over the standard Interrupt Request (\overline{IRQ}) , and is fast in the sense that it stacks only the contents of the condition code register and the program counter. The interrupt service routine should clear the source of the interrupt before doing an RTI. See Figure 10.

INTERRUPT REQUEST (IRQ)*

A low level input on this pin will initiate an Interrupt Request sequence provided the mask bit (I) in the CC is clear. Since $\overline{\text{IRO}}$ stacks the entire machine state it provides a slower response to interrupts than $\overline{\text{FIRO}}$. $\overline{\text{IRO}}$ also has a lower priority than $\overline{\text{FIRO}}$. Again, the interrupt service routine should clear the source of the interrupt before doing an RTI. See Figure 9.

CLOCK INPUTS E, Q

E and Q are the clock signals required by the MC6809E. Q must lead E; that is, a transition on Q must be followed by a similar transition on E after a minimum delay. Addresses will be valid from the MPU, tAD after the falling edge of E, and data will be latched from the bus by the falling edge of E. While the Q input is fully TTL compatible, the E input directly drives internal MOS circuitry and, thus, requires a high level above normal TTL levels. This approach minimizes clock skew inherent with an internal buffer. Timing and waveforms for E and Q are shown in Figure 2 while Figure 11 shows a simple clock generator for the MC6809E.

BUSY

Busy will be high for the read and modify cycles of a readmodify-write instruction and during the access of the first byte of a double-byte operation (e.g., LDX, STD, ADDD). Busy is also high during the first byte of any indirect or other vector fetch (e.g., jump extended, SWI indirect etc.).

In a multi-processor system, busy indicates the need to

defer the rearbitration of the next bus cycle to insure the integrity of the above operations. This difference provides the indivisible memory access required for a "test-and-set" primitive, using any one of several read-modify-write instructions

Busy does not become active during PSH or PUL operations. A typical read-modify-write instruction (ASL) is shown in Figure 12. Timing information is given in Figure 13. Busy is valid t_{CD} after the rising edge of Q.

AVMA

AVMA is the Advanced VMA signal and indicates that the MPU will use the bus in the following bus cycle. The predictive nature of the AVMA signal allows efficient shared-bus multiprocessor systems. AVMA is LOW when the MPU is in either a HALT or SYNC state. AVMA is valid t_{CD} after the rising edge of Q.

LIC

LIC (Last Instruction Cycle) is HIGH during the last cycle of every instruction, and its transition from HIGH to LOW will indicate that the first byte of an opcode will be latched at the end of the present bus cycle. LIC will be HIGH when the MPU is Halted at the end of an instruction, (i.e., not in CWAI or RESET) in SYNC state or while stacking during interrupts LIC is valid top after the rising edge of Q.

TSC

TSC (Three-State Control) will cause MOS address, data, and R/\overline{W} buffers to assume a high-impedance state. The control signals (BA, BS, BUSY, AVMA and LIC) will not go to the high-impedance state. TSC is intended to allow a single bus to be shared with other bus masters (processors or DMA controllers).

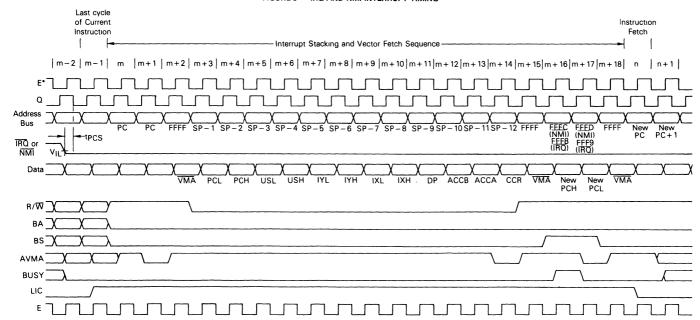
While E is low, TSC controls the address buffers and R/W directly. The data bus buffers during a write operation are in a high-impedance state until Q rises at which time, if TSC is true, they will remain in a high-impedance state. If TSC is held beyond the rising edge of E, then it will be internally latched, keeping the bus drivers in a high-impedance state for the remainder of the bus cycle. See Figure 14.

MPU OPERATION

During normal operation, the MPU fetches an instruction from memory and then executes the requested function. This sequence begins after RESET and is repeated indefinitely unless altered by a special instruction or hardware occurrence. Software instructions that alter normal MPU operation are: SWI, SWI2, SWI3, CWAI, RTI and SYNC. An interrupt or HALT input can also alter the normal execution of instructions. Figure 15 is the flow chart for the MC6809E

^{*}NMI, FIRQ, and IRQ requests are sampled on the falling edge of Q. One cycle is required for synchronization before these interrupts are recognized. The pending interrupt(s) will not be serviced until completion of the current instruction unless a SYNC or CWAI condition is present. If IRQ and FIRQ do not remain low until completion of the current instruction they may not be recognized. However, NMI is latched and need only remain low for one cycle. No interrupts are recognized or latched between the falling edge of RESET and the rising edge of BS indicating RESET acknowledge. See RESET sequence in the MPU flowchart in Figure 15.

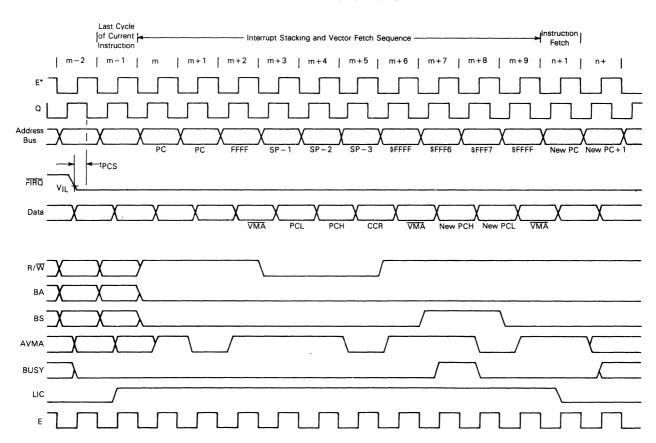
FIGURE 9 - IRO AND NMI INTERRUPT TIMING



^{*}E clock shown for reference only

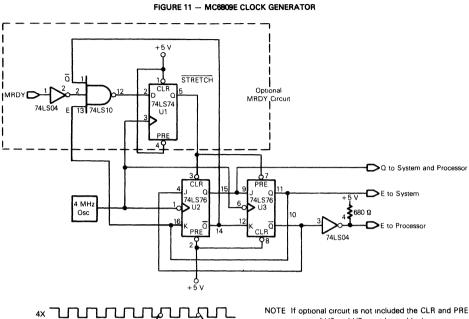
NOTE Timing measurements are referenced to and from a low voltage of 0.8 volts and a high voltage of 2.0 volts, unless otherwise noted

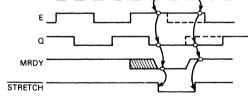
FIGURE 10 - FIRO INTERRUPT TIMING



^{*}E clock shown for reference only

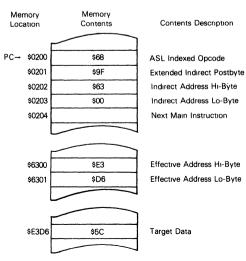
NOTE Timing measurements are referenced to and from a low voltage of 0.8 volts and a high voltage of 2.0 volts, unless otherwise noted.

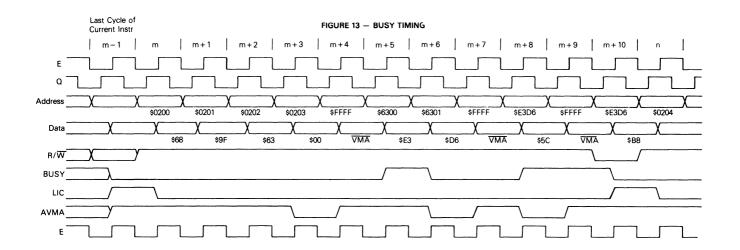




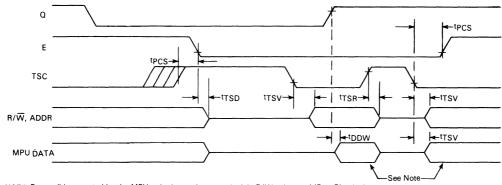
inputs of U2 and U3 must be tied high

FIGURE 12 - READ-MODIFY-WRITE INSTRUCTION EXAMPLE (ASL EXTENDED INDIRECT)









NOTE Data will be asserted by the MPU only during the interval while R/W is low and (E or Q) is high
A composite bus cycle is shown to give most cases of timing
Timing measurements are referenced to and from a low voltage of 0.8 volts and a high voltage of 2.0 volts, unitess otherwise noted

FIRQ+F Reset Seq Stack PC, U, Y, X, DP, B, A, CC Latch Interrupts 1 →R W Cir NMI Logic Disarm NMI D CWAI 1-BA 1-BS 0+BA 0+BS Cir NMI Logic 0-BA 1-BS 0-BA 1-BS Note 2 Vector-PC (Vector) → PC Reset FFFE NMI FFFC 1-LIC SWI FFFA IRQ FFF8 0-BS FIRQ FFF6 Unstack CC SWI2 FFF4 1-F I 1-+F I 1-1 SWI3 FFF2 C 0-BS +CC+CC Latch 0-BA, BS 1 -BA, BS D Execution 0-BS 1-BS HALT **Bus State** BA BS Running 0 0 Interrupt or Reset Acknowledge 0 Sync Acknowledge 0 Halt Acknowledge Notes 1 Asserting RESET will result in entering the reset sequence from any point in the flow chart 2 BUSY is high during first vector fetch cycle

FIGURE 15 - FLOWCHART FOR MC6809E INSTRUCTIONS

7

ADDRESSING MODES

The basic instructions of any computer are greatly enhanced by the presence of powerful addressing modes The MC6809E has the most complete set of addressing modes available on any microcomputer today. For example, the MC6809E has 59 basic instructions, however, it recognizes 1464 different variations of instructions and addressing modes. The addressing modes support modern programming techniques. The following addressing modes are available on the MC6809E.

Inherent (Includes Accumulator)

Immediate

Extended

Extended Indirect

Direct

Register

Indexed

Zero-Offset

Constant Offset

Accumulator Offset

Auto Increment/Decrement

Indexed Indirect

Relative

Short/Long Relative Branching

Program Counter Relative Addressing

INHERENT (INCLUDES ACCUMULATOR)

In this addressing mode, the opcode of the instruction contains all the address information necessary. Examples of Inherent Addressing are ABX, DAA, SWI, ASRA, and CLRB

IMMEDIATE ADDRESSING

In Immediate Addressing, the effective address of the data is the location immediately following the opcode (i.e., the data to be used in the instruction immediately follows the opcode of the instruction) The MC6809E uses both 8 and 16-bit immediate values depending on the size of argument specified by the opcode Examples of instructions with Immediate Addressing are

LDA #\$20 LDX #\$F000 LDY #CAT

NOTE: # signifies Immediate addressing, \$ signifies hexadecimal value to the MC6809 assembler.

EXTENDED ADDRESSING

In Extended Addressing, the contents of the two bytes immediately following the opcode fully specify the 16-bit effective address used by the instruction. Note that the address generated by an extended instruction defines an absolute address and is not position independent. Examples of Extended Addressing include:

LDA CAT STX MOUSE LDD \$2000

EXTENDED INDIRECT

As a special case of indexed addressing (discussed below), one level of indirection may be added to Extended Addressing In Extended Indirect, the two bytes following the postbyte of an Indexed instruction contain the address of the data

LDA [CAT] LDX [\$FFFE] STU [DOG]

DIRECT ADDRESSING

Direct addressing is similar to extended addressing except that only one byte of address follows the opcode. This byte specifies the lower 8 bits of the address to be used. The upper 8 bits of the address are supplied by the direct page register. Since only one byte of address is required in direct addressing, this mode requires less memory and executes faster than extended addressing. Of course, only 256 locations (one page) can be accessed without redefining the contents of the DP register. Since the DP register is set to \$00 on Reset, direct addressing on the MC6809E is upward compatible with direct addressing on the M6800 Indirection is not allowed in direct addressing. Some examples of direct addressing are:

LDA where DP = \$00 LDB where DP = \$10< CAT

LDD

NOTE: < is an assembler directive which forces direct addressing

REGISTER ADDRESSING

Some opcodes are followed by a byte that defines a register or set of registers to be used by the instruction. This is called a postbyte. Some examples of register addressing

TFR X, Y Transfers X into Y EXG A. B Exchanges A with B A, B, X, Y Push Y, X, B and A onto S **PSHS** PULU X, Y, D Pull D, X, and Y from U stack

INDEXED ADDRESSING

In all indexed addressing, one of the pointer registers (X, Y, U, S, and sometimes PC) is used in a calculation of the effective address of the operand to be used by the instruction Five basic types of indexing are available and are discussed below. The postbyte of an indexed instruction specifies the basic type and variation of the addressing mode as well as the pointer register to be used. Figure 16 lists the legal formats for the postbyte Table 2 gives the assembler form and the number of cycles and bytes added to the basic values for indexed addressing for each variation

MC6809E•MC68A09E•MC68B09E

FIGURE 16 — INDEXED ADDRESSING POSTBYTE REGISTER BIT ASSIGNMENTS

| | Post-Byte Register Bit | | | | | | | Indexed |
|---|------------------------|---|-----|---|---|---|---|--------------------------|
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | Addressing Mode |
| 0 | R | R | d | d | d | d | d | EA = R + 5 Bit Offset |
| 1 | R | R | 0 | 0 | 0 | 0 | 0 | ,R+ |
| 1 | R | R | - | 0 | 0 | 0 | 1 | ,R++ |
| 1 | R | R | 0 | 0 | 0 | 1 | 0 | , – R |
| 1 | R | R | ı | 0 | 0 | 1 | 1 | , – – R |
| 1 | R | R | - | 0 | 1 | 0 | 0 | EA = R + 0 Offset |
| 1 | R | R | _ | 0 | 1 | 0 | 1 | EA = ,R + ACCB Offset |
| 1 | R | R | 1 | 0 | 1 | 1 | 0 | EA = ,R + ACCA Offset |
| 1 | R | R | 1 | 1 | 0 | 0 | 0 | EA = R + 8 Bit Offset |
| 1 | R | R | 1 | 1 | 0 | 0 | 1 | EA = ,R + 16 Bit Offset |
| 1 | R | R | _ | 1 | 0 | 1 | 1 | EA = R + D Offset |
| 1 | х | × | I, | 1 | 1 | 0 | 0 | EA = ,PC +8 Bit Offset |
| 1 | х | х | 1 | 1 | 1 | 0 | 1 | EA = ,PC + 16 Bit Offset |
| 1 | R | R | - 1 | 1 | 1 | 1 | 1 | EA = [,Address] |
| Addressing Mode Field Indirect Field (Sign bit when b ₇ = 0) | | | | | | | | |
| Register Field RR 00 = X 01 = Y | | | | | | | | |

x = Don't Care d = Offset Bit

i = 0 = Not Indirect 1 = Indirect **Zero-Offset Indexed** — In this mode, the selected pointer register contains the effective address of the data to be used by the instruction. This is the fastest indexing mode.

Examples are LDD 0, X LDA ,S

Constant Offset Indexed — In this mode, a two's-complement offset and the contents of one of the pointer registers are added to form the effective address of the operand. The pointer register's initial content is unchanged by the addition

Three sizes of offsets are available

5 -bit (-16 to +15) 8 -bit (-128 to +127) 16-bit (-32768 to +32767)

The two's complement 5-bit offset is included in the postbyte and, therefore, is most efficient in use of bytes and cycles. The two's complement 8-bit offset is contained in a single byte following the postbyte. The two's complement 16-bit offset is in the two bytes following the postbyte. In most cases the programmer need not be concerned with the size of this offset since the assembler will select the optimal size automatically.

Examples of constant-offset indexing are:

LDA 23,X LDX -2,S LDY 300,X LDU CAT,Y

TABLE 2 - INDEXED ADDRESSING MODE

10 = U

11 = S

| | | No | n Indirect | Indirect | | | | | |
|----------------------------|-------------------|-------------------|---------------------|----------|-----|-------------------|---------------------|-----|-------|
| Туре | Forms | Assembler Form | Postbyte OP Code | + ~ | + # | Assembler Form | Postbyte OP Code | + ~ | 1 : 1 |
| Constant Offset From R | No Offset | ,R | 1RR00100 | 0 | 0 | [,R] | 1RR10100 | 3 | 0 |
| (2's Complement Offsets) | 5 Bit Offset | n, R | 0RRnnnnn | 1 | 0 | defaults | to 8-bit | | |
| | 8 Bit Offset | n, R | 1RR01000 | 1 | 1 | [n, R] | 1RR11000 | 4 | 1 |
| | 16 Bit Offset | n, R | 1RR01001 | 4 | 2 | (n, R) | 1RR11001 | 7 | 2 |
| Accumulator Offset From R | A Register Offset | A, R | 1RR00110 | 1 | 0 | [A, R] | 1RR10110 | 4 | 0 |
| (2's Complement Offsets) | B Register Offset | B, R | 1RR00101 | 1 | 0 | [B, R] | 1RR10101 | 4 | 0 |
| | D Register Offset | D, R | 1RR01011 | 4 | 0 | [D, R] | 1RR11011 | 7 | 0 |
| Auto Increment/Decrement R | Increment By 1 | ,R+ | 1RR00000 | 2 | 0 | not all | owed | | |
| | Increment By 2 | ,R++ | 1RR00001 | 3 | 0 | [,R++] | 1RR10001 | 6 | 0 |
| | Decrement By 1 | , ,–R | 1RR00010 | 2 | 0 | not all | owed | | |
| | Decrement By 2 | , – – R | 1RR00011 | 3 | 0 | [, R] | 1RR10011 | 6 | 0 |
| Constant Offset From PC | 8 Bit Offset | n, PCR | 1xx01100 | 1 | 1 | [n, PCR] | 1xx11100 | 4 | 1 |
| (2's Complement Offsets) | 16 Bit Offset | n, PCR | 1xx01101 | 5 | 2 | [n, PCR] | 1xx11101 | 8 | 2 |
| Extended Indirect | 16 Bit Address | _ | _ | - | - | [n] | 10011111 | 5 | 2 |

R = X, Y, U or S RR x = Don't Care 00 = X 01 = Y 10 = U 11 = S

 $[\]stackrel{+}{\sim}$ and $\stackrel{+}{}_{\rlap{\slash}}$ indicate the number of additional cycles and bytes respectively for the particular indexing variation

Accumulator-Offset Indexed - This mode is similar to constant offset indexed except that the two's-complement value in one of the accumulators (A, B or D) and the contents of one of the pointer registers are added to form the effective address of the operand. The contents of both the accumulator and the pointer register are unchanged by the addition. The postbyte specifies which accumulator to use as an offset and no additional bytes are required. The advantage of an accumulator offset is that the value of the offset can be calculated by a program at run-time

Some examples are:

B,Y LDA LDX D,Y LEAX B,X

Auto Increment/Decrement Indexed - In the auto increment addressing mode, the pointer register contains the address of the operand. Then, after the pointer register is used it is incremented by one or two. This addressing mode is useful in stepping through tables, moving data, or for the creation of software stacks. In auto decrement, the pointer register is decremented prior to use as the address of the data The use of auto decrement is similar to that of auto increment, but the tables, etc., are scanned from the high to low addresses. The size of the increment/decrement can be either one or two to allow for tables of either 8- or 16-bit data to be accessed and is selectable by the programmer. The pre-decrement, post-increment nature of these modes allow them to be used to create additional software stacks that behave identically to the U and S stacks

Some examples of the auto increment/decrement addressing modes are:

LDA ,Y++ STD LDB LDX

Care should be taken in performing operations on 16-bit pointer registers (X, Y, U, S) where the same register is used to calculate the effective address

Consider the following instruction

STX 0,X++ (X initialized to 0)

The desired result is to store a 0 in locations \$0000 and \$0001 then increment X to point to \$0002 In reality, the following occurs

0→temp

calculate the EA, temp is a holding register

 $X + 2 \rightarrow X$ perform autoincrement $X \rightarrow (temp)$

do store operation

INDEXED INDIRECT

All of the indexing modes with the exception of auto increment/decrement by one, or a ±5-bit offset may have an additional level of indirection specified. In indirect addressing, the effective address is contained at the location specified by the contents of the Index Register plus any offset In the example below, the A accumulator is loaded indirectly using an effective address calculated from the Index Register and an offset.

> Before Execution A = XX (don't)care) X = \$F000

\$0100 LDA [\$10,X] EA is now \$F010 \$F150 is now the \$F010 \$F1 \$F011 \$50 new FA \$F150 SΑΑ

> After Execution A = \$AA (Actual Data Loaded) X = \$F000

All modes of indexed indirect are included except those which are meaningless (e.g., auto increment/decrement by 1 indirect). Some examples of indexed indirect are

LDA [,X] LDD [10.S] LDA [B,Y] IDD [X + + X]

RELATIVE ADDRESSING

The byte(s) following the branch opcode is (are) treated as a signed offset which may be added to the program counter. If the branch condition is true then the calculated address (PC + signed offset) is loaded into the program counter Program execution continues at the new location as indicated by the PC; short (1 byte offset) and long (2 bytes offset) relative addressing modes are available. All of memory can be reached in long relative addressing as an effective address interpreted modulo 216 Some examples of relative addressing are:

| | BEQ | CAT | (short) |
|--------|------|--------|---------|
| | BGT | DOG | (short) |
| CAT | LBEQ | RAT | (long) |
| DOG | LBGT | RABBIT | (long) |
| | • | | |
| | • | | |
| | • | | |
| RAT | NOP | | |
| RABBIT | NOP | | |

PROGRAM COUNTER RELATIVE

The PC can be used as the pointer register with 8 or 16-bit signed offsets. As in relative addressing, the offset is added to the current PC to create the effective address. The effective address is then used as the address of the operand or data Program Counter Relative Addressing is used for writing position independent programs. Tables related to a particular routine will maintain the same relationship after the routine is moved, if referenced relative to the Program Counter Examples are

LDA CAT, PCR LEAX TABLE, PCR

Since program counter relative is a type of indexing, an additional level of indirection is available

> LDA [CAT, PCR] LDU [DOG, PCR]

MC6809E INSTRUCTION SET

The instruction set of the MC6809E is similar to that of the MC6800 and is upward compatible at the source code level. The number of opcodes has been reduced from 72 to 59, but because of the expanded architecture and additional addressing modes, the number of available opcodes (with different addressing modes) has risen from 197 to 1464.

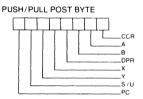
Some of the new instructions are described in detail below:

PSHU/PSHS

The push instructions have the capability of pushing onto either the hardware stack (S) or user stack (U) any single register, or set of registers with a single instruction

PULU/PULS

The pull instructions have the same capability of the push instruction, in reverse order. The byte immediately following the push or pull opcode determines which register or registers are to be pushed or pulled. The actual PUSH/PULL sequence is fixed; each bit defines a unique register to push or pull, as shown below





TFR/EXG

Within the MC6809E, any register may be transferred to or exchanged with another of like-size; i.e., 8-bit to 8-bit or 16-bit to 16-bit. Bits 4-7 of postbyte define the source register, while bits 0-3 represent the destination register. These are denoted as follows:

TRANSFER/EXCHANGE POST BYTE

| sc | URCE | DESTINATI | ON | | | | | |
|------|----------------|-----------|-----|--|--|--|--|--|
| | REGISTER FIELD | | | | | | | |
| H | EGISTE | HFIELD | | | | | | |
| 0000 | D(AB) | 1000 | Α | | | | | |
| 0001 | X | 1001 | В | | | | | |
| 0010 | Υ | 1010 | CCR | | | | | |
| 0011 | U | 1011 | DPR | | | | | |
| 0100 | S | | | | | | | |
| 0101 | PC | | | | | | | |

NOTE: All other combinations are undefined and INVALID

LEAX/LEAY/LEAU/LEAS

The LEA (Load Effective Address) works by calculating the effective address used in an indexed instruction and stores that address value, rather than the data at that address, in a pointer register. This makes all the features of the internal addressing hardware available to the programmer Some of the implications of this instruction are illustrated in Table 3.

The LEA instruction also allows the user to access data and tables in a position independent manner. For example:

LEAX MSG1, PCR
LBSR PDATA (Print message routine)

MSG1 FCC 'MESSAGE'

This sample program prints 'MESSAGE' By writing MSG1, PCR, the assembler computes the distance between the present address and MSG1. This result is placed as a constant into the LEAX instruction which will be indexed from the PC value at the time of execution. No matter where the code is located, when it is executed, the computed offset from the PC will put the absolute address of MSG1 into the X pointer register. This code is totally position independent

The LEA instructions are very powerful and use an internal holding register (temp). Care must be exercised when using the LEA instructions with the autoincrement and autodecrement addressing modes due to the sequence of internal operations. The LEA internal sequence is outlined as follows LEAa, b+ (any of the 16-bit pointer registers X, Y, U

or S may be substituted for a and b)

1 b—temp (calculate the EA)

2 b+1-b (modify b, postincrement)

3 temp→a (load a)

LEAa . - b

1 b-1→temp (calculate EA with predecrement)

2. $b-1\rightarrow b$ (modify b, predecrement)

3 temp→a (load a)

TABLE 3 - LEA EXAMPLES

| Instruction | Operation | Comment |
|--------------|-------------|--------------------------------|
| LEAX 10, X | X + 10 → X | Adds 5-bit constant 10 to X |
| LEAX 500, X | X + 500 → X | Adds 16-bit constant 500 to X |
| LEAY A, Y | Y + A → Y | Adds 8-bit A accumulator to Y |
| LEAY D, Y | Y+D →Y | Adds 16-bit D accumulator to Y |
| LEAU - 10, U | U - 10 → U | Subtracts 10 from U |
| LEAS - 10, S | S - 10 → S | Used to reserve area on stack |
| LEAS 10, S | S + 10 → S | Used to 'clean up' stack |
| LEAX 5, S | S + 5 → X | Transfers as well as adds |

Autoincrement-by-two and autodecrement-by-two instructions work similarly. Note that LEAX ,X + does not change X, however LEAX , - X does decrement X LEAX 1,X should be used to increment X by one

MUL

Multiplies the unsigned binary numbers in the A and B accumulator and places the unsigned result into the 16-bit D accumulator. This unsigned multiply also allows multiple-precision multiplications

Long And Short Relative Branches

The MC6809E has the capability of program counter relative branching throughout the entire memory map. In this mode, if the branch is to be taken, the 8 or 16-bit signed offset is added to the value of the program counter to be used as the effective address. This allows the program to branch anywhere in the 64K memory map. Position independent code can be easily generated through the use of relative branching. Both short (8-bit) and long (16-bit) branches are available.

SYNC

After encountering a Sync instruction, the MPU enters a Sync state, stops processing instructions and waits for an interrupt. If the pending interrupt is non-maskable (NMI) or maskable (FIRQ, IRQ) with its mask bit (F or I) clear, the processor will clear the Sync state and perform the normal interrupt stacking and service routine. Since FIRQ and IRQ are not edge-triggered, a low level with a minimum duration of three bus cycles is required to assure that the interrupt will be taken. If the pending interrupt is maskable (FIRQ, IRQ) with its mask bit (F or I) set, the processor will clear the Sync state and continue processing by executing the next inline instruction. Figure 17 depicts Sync timing.

Software interrupts

A Software Interrupt is an instruction which will cause an interrupt, and its associated vector fetch. These Software Interrupts are useful in operating system calls, software debugging, trace operations, memory mapping, and software development systems. Three levels of SWI are available on this MC6809E, and are prioritized in the following order SWI, SWI2, SWI3

16-Bit Operation

The MC6809E has the capability of processing 16-bit data. These instructions include loads, stores, compares, adds, subtracts, transfers, exchanges, pushes and pulls

CYCLE-BY-CYCLE OPERATION

The address bus cycle-by-cycle performance chart illustrates the memory-access sequence corresponding to each possible instruction and addressing mode in the MC6809E Each instruction begins with an opcode fetch. While that opcode is being internally decoded, the next program byte is always fetched (Most instructions will use the next byte, so this technique considerably speeds throughput.) Next, the operation of each opcode will follow the flow chart. VMA is an indication of FFFF16 on the ad-

dress bus, $R/\overline{W} = 1$ and BS = 0. The following examples illustrate the use of the chart; see Figure 18.

Example 1: LBSR (Branch Taken)
Before Execution SP = F000

| | | • | |
|--------|-----|------|-----|
| | | • | |
| | | • | |
| \$8000 | | LBSR | CAT |
| | | • | |
| | | • | |
| | | • | |
| \$4000 | CAT | • | |

CYCLE-BY-CYCLE FLOW

| Cycle # | Address | Data | R/W | Description |
|---------|---------|------|-----|--------------------------|
| 1 | 8000 | 17 | 1 | Opcode Fetch |
| 2 | 8001 | 20 | 1 | Offset High Byte |
| 3 | 8002 | 00 | 1 | Offset Low Byte |
| 4 | FFFF | • | 1 | VMA Cycle |
| 5 | FFFF | • | 1 | VMA Cycle |
| 6 | A000 | • | 1 | Computed Branch Address |
| 7 | FFFF | • | 1 | VMA Cycle |
| 8 | EFFF | 80 | 0 | Stack High Order Byte of |
| | | | | Return Address |
| 9 | EFFE | 03 | 0 | Stack Low Order Byte of |
| | | | | Return Address |

Example 2: DEC (Extended)

| \$8000 | DEC | \$A000 |
|--------|-----|--------|
| \$A000 | FCB | \$80 |

CYCLE-BY-CYCLE FLOW

| Cycle # | Address | Data | R/W | Description |
|---------|---------|------|-----|----------------------------|
| 1 | 8000 | 7A | 1 | Opcode Fetch |
| 2 | 8001 | A0 | 1 | Operand Address, High Byte |
| 3 | 8002 | 00 | 1 | Operand Address, Low Byte |
| 4 | FFFF | • | 1 | VMA Cycle |
| 5 | A000 | 80 | 1 | Read the Data |
| 6 | FFFF | • | 1 | VMA Cycle |
| 7 | A000 | 7F | 0 | Store the Decremented Data |

^{*}The data bus has the data at that particular address

MC6809E INSTRUCTION SET TABLES

The instructions of the MC6809E have been broken down into five different categories. They are as follows.

8-Bit operation (Table 4) 16-Bit operation (Table 5)

Index register/stack pointer instructions (Table 6) Relative branches (long or short) (Table 7)

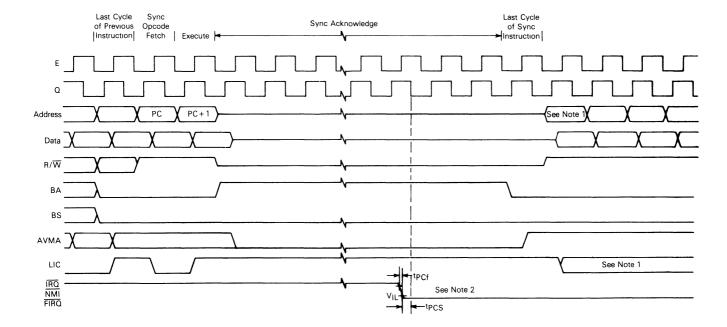
Miscellaneous instructions (Table 8)

Hexadecimal values for the instructions are given in Table 9.

PROGRAMMING AID

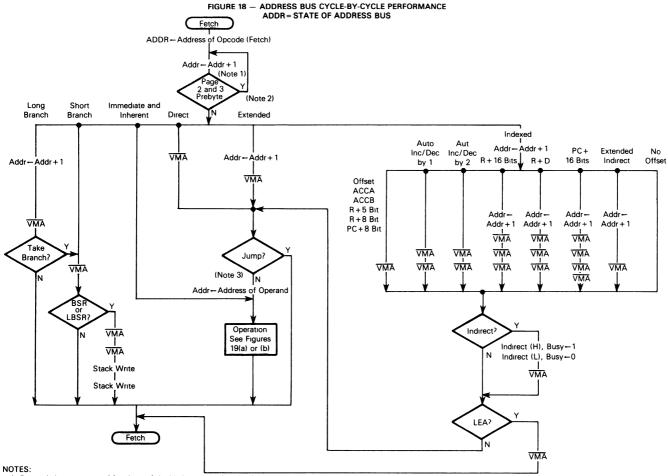
Figure 18 contains a compilation of data that will assist you in programming the MC6809E

FIGURE 17 - SYNC TIMING



- Notes 1 If the associated mask bit is set when the interrupt is requested, LIC will go low and this cycle will be an instruction fetch from address location PC+1 However, if the interrupt is accepted (NMI) or an unmasked FIRQ or IRQ) LIC will remain high and interrupt processing will start with this cycle as (m) on Figures 9 and 10 (Interrupt Timing)
 - 2 If mask bits are clear, IRO and FIRO must be held low for three cycles to guarantee that interrupt will be taken, although only one cycle is necessary to bring the processor out of SYNC

NOTE Timing measurements are referenced to and from a low voltage of 0.8 volts and a high voltage of 2.0 volts, unless otherwise noted



- 1 Busy = 1 during access of first byte of double byte immediate load.
- 2. All subsequent Page 2 and Page 3 prebytes will be ignored after initial opcode fetch
- 3 Write operation during store instruction. Busy = 1 during first two cycles of a double-byte access and the first cycle of read-modify-write access
- 4. AVMA is asserted on the cycle before a VMA cycle

Inherent Page From Figure 18 PSHU PULU SWI2 ABX RTS TFR EXG MUL **PSHS** SWI3 **CWAI PULS** RTJ ASLA **ASLB** ASRA **ASRB** ADDR STACK (R) CLRA VMA CLRB **∀MA VMA ∀MA** VMA VMA COMA VMA COMB **VMA** VMA VMA DAA \overline{VMA} DECA DECB STACK(W) STACK(W) INCA STACK (R) VMA VMA ADDR - SP STACK(W) STACK(W) INCB STACK (R) \overline{VMA} VMA STACK(W) STACK(W) LSLA VMA VMA {Stack (W)} 12 VMA STACK (R) STACK(W) STACK(W) LSLB VMA VMA STACK (R) Note 3 STACK(W) STACK(W) LSRA VMA Stack (R) 12 STACK (W) STACK (W) Note 3 STACK (W) STACK (W) **VMA** STACK (R) LSRB VMA VMA STACK (R) NEGA VMA STACK (R) STACK(W) STACK(W) NEGB VMA STACK (R) STACK (R) STACK(W) STACK(W) NOP VMA STACK (R) STACK (R) STACK(W) STACK(W) ROLA STACK (R) STACK(W) STACK(W) ROLB STACK (R) STACK(W) STACK(W) RORA STACK (R) RORB ADDR-SP STACK (R) SEX ıVMAı∞ VMA Note 4 VECTOR (H), VECTOR (H), BUSY-1 BUSY-1 Addr - SP VECTOR (L), VECTOR (L). BUSY-0 BUSY ←0 **∀MA** VMA

FIGURE 19(a) - OPERATIONS. ADDRESS BUS CYCLE-BY-CYCLE PERFORMANCE

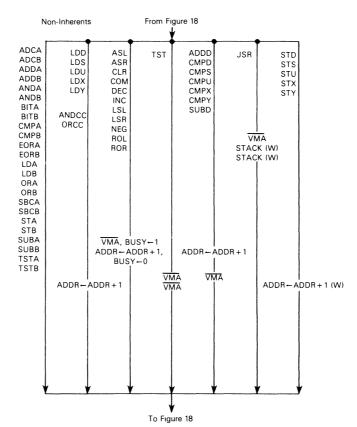
NOTES

- 1 Stack (W) refers to the following sequence SP SP 1, then ADDR SP with $R/\overline{W} = 0$ Stack (R) refers to the following sequence ADDR SP with $R/\overline{W} = 1$, then SP SP + 1
- PSHU, PULU instructions use the user stack pointer (i e , SP≡U) and PSHS, PULS use the hardware stack pointer (i e , SP≡S)

To Figure 18

- 2 Vector refers to the address of an interrupt or reset vector (see Table 1)
- 3 The number of stack accesses will vary according to the number of bytes saved
- 4 VMA cycles will occur until an interrupt occurs

FIGURE 19(b) — OPERATIONS: ADDRESS BUS CYCLE-BY-CYCLE PERFORMANCE



NOTES

- 1 Stack (W) refers to the following sequence SP-SP-1, then ADDR-SP with R/W=0 Stack (R) refers to the following sequence, ADDR-SP with R/W=1, then SP-SP+1 PSHU, PUL'J instructions use the user stack pointer (i.e., SP=U) and PSHS, PULS use the hardware stack pointer (i.e., SP=S)
- 2 Vector refers to the address of an interrupt or reset vector (see Table 1)
- 3 The number of stack accesses will vary according to the number of bytes saved
- 4 VMA cycles will occur until an interrupt occurs

MC6809E•MC68A09E•MC68B09E

TABLE 4 - 8-BIT ACCUMULATOR AND MEMORY INSTRUCTIONS

| Mnemonic(s) | Operation |
|-----------------|--|
| ADCA, ADCB | Add memory to accumulator with carry |
| ADDA, ADDB | Add memory to accumulator |
| ANDA, ANDB | And memory with accumulator |
| ASL, ASLA, ASLB | Arithmetic shift of accumulator or memory left |
| ASR, ASRA, ASRB | Arithmetic shift of accumulator or memory right |
| BITA, BITB | Bit test memory with accumulator |
| CLR, CLRA, CLRB | Clear accumulator or memory location |
| СМРА, СМРВ | Compare memory from accumulator |
| COM, COMA, COMB | Complement accumulator or memory location |
| DAA | Decimal adjust A accumulator |
| DEC, DECA, DECB | Decrement accumulator or memory location |
| EORA, EORB | Exclusive or memory with accumulator |
| EXG R1, R2 | Exchange R1 with R2 (R1, R2 = A, B, CC, DP) |
| INC, INCA, INCB | Increment accumulator or memory location |
| LDA, LDB | Load accumulator from memory |
| LSL, LSLA, LSLB | Logical shift left accumulator or memory location |
| LSR, LSRA, LSRB | Logical shift right accumulator or memory location |
| MUL | Unsigned multiply (A \times B \rightarrow D) |
| NEG, NEGA, NEGB | Negate accumulator or memory |
| ORA, ORB | Or memory with accumulator , |
| ROL, ROLA, ROLB | Rotate accumulator or memory left |
| ROR, RORA, RORB | Rotate accumulator or memory right |
| SBCA, SBCB | Subtract memory from accumulator with borrow |
| STA, STB | Store accumulator to memory |
| SUBA, SUBB | Subtract memory from accumulator |
| TST, TSTA, TSTB | Test accumulator or memory location |
| TFR R1, R2 | Transfer R1 to R2 (R1, R2 = A, B, CC, DP) |

NOTE A, B, CC or DP may be pushed to (pulled from) either stack with PSHS, PSHU (PULS, PULU) instructions

TABLE 5 - 16-BIT ACCUMULATOR AND MEMORY INSTRUCTIONS

| Mnemonic(s) | Operation |
|-------------|--|
| ADDD | Add memory to D accumulator |
| CMPD | Compare memory from D accumulator |
| EXG D, R | Exchange D with X, Y, S, U or PC |
| LDD | Load D accumulator from memory |
| SEX | Sign Extend B accumulator into A accumulator |
| STD | Store D accumulator to memory |
| SUBD | Subtract memory from D accumulator |
| TFR D, R | Transfer D to X, Y, S, U or PC |
| TFR R, D | Transfer X, Y, S, U or PC to D |

NOTE D may be pushed (pulled) to either stack with PSHS, PSHU (PULS, PULU) instructions

TABLE 6 - INDEX REGISTER/STACK POINTER INSTRUCTIONS

| Instruction | Description |
|-------------|--|
| CMPS, CMPU | Compare memory from stack pointer |
| CMPX, CMPY | Compare memory from index register |
| EXG R1, R2 | Exchange D, X, Y, S, U or PC with D, X, Y, S, U or PC |
| LEAS, LEAU | Load effective address into stack pointer |
| LEAX, LEAY | Load effective address into index register |
| LDS, LDU | Load stack pointer from memory |
| LDX, LDY | Load index register from memory |
| PSHS | Push A, B, CC, DP, D, X, Y, U, or PC onto hardware stack |
| PSHU | Push A, B, CC, DP, D, X, Y, S, or PC onto user stack |
| PULS | Pull A, B, CC, DP, D, X, Y, U or PC from hardware stack |
| PULU | Pull A, B, CC, DP, D, X, Y, S or PC from hardware stack |
| STS, STU | Store stack pointer to memory |
| STX, STY | Store index register to memory |
| TFR R1, R2 | Transfer D, X, Y, S, U or PC to D, X, Y, S, U or PC |
| ABX | Add B accumulator to X (unsigned) |

TABLE 7 - BRANCH INSTRUCTIONS

| Instruction | Description |
|-------------|--|
| | SIMPLE BRANCHES |
| BEQ, LBEQ | Branch if equal |
| BNE, LBNE | Branch if not equal |
| BMI, LBMI | Branch if minus |
| BPL, LBPL | Branch if plus |
| BCS, LBCS | Branch if carry set |
| BCC, LBCC | Branch if carry clear |
| BVS, LBVS | Branch if overflow set |
| BVC, LBVC | Branch if overflow clear |
| | SIGNED BRANCHES |
| BGT, LBGT | Branch if greater (signed) |
| BVS, LBVS | Branch if invalid 2's complement result |
| BGE, LBGE | Branch if greater than or equal (signed) |
| BEQ, LBEQ | Branch if equal |
| BNE, LBNE | Branch if not equal |
| BLE, LBLE | Branch if less than or equal (signed) |
| BVC, LBVC | Branch if valid 2's complement result |
| BLT, LBLT | Branch if less than (signed) |
| | UNSIGNED BRANCHES |
| BHI, LBHI | Branch if higher (unsigned) |
| BCC, LBCC | Branch if higher or same (unsigned) |
| BHS, LBHS | Branch if higher or same (unsigned) |
| BEQ, LBEQ | Branch if equal |
| BNE, LBNE | Branch if not equal |
| BLS, LBLS | Branch if lower or same (unsigned) |
| BCS, LBCS | Branch if lower (unsigned) |
| BLO, LBLO | Branch if lower (unsigned) |
| | OTHER BRANCHES |
| BSR, LBSR | Branch to subroutine |
| BRA, LBRA | Branch always |
| BRN, LBRN | Branch never |

TABLE 8 - MISCELLANEOUS INSTRUCTIONS

| .,, | ABEL O MICCELLANZOGO MO MICHIGONOMO | |
|-----------------|--|--|
| Instruction | Description | |
| ANDCC | AND condition code register | |
| CWAI | AND condition code register, then wait for interrupt | |
| NOP | No operation | |
| ORCC | OR condition code register | |
| JMP | Jump | |
| JSR | Jump to subroutine | |
| RTI | Return from interrupt | |
| RTS | Return from subroutine | |
| SWI, SWI2, SWI3 | Software interrupt (absolute indirect) | |
| SYNC | Synchronize with interrupt line | |

TABLE 9 - HEXADECIMAL VALUES OF MACHINE CODES

| OP | | 14.4. | | | 0.0 | | | | | OP | | | | |
|----------|----------|----------|----|---|----------|--------------|-----------|------------|----|------------|------------|----------|----------|----------|
| | Mnem | Mode | ~ | # | OP | Mnem | Mode | ~ | # | | Mnem | Mode | ~ | # |
| 00 | NEG | Direct | 6 | 2 | 30 | LEAX | Indexed | 4+ | 2+ | 60 | NEG • | Indexed | 6+ | 2+ |
| 01 | | T | | | 31 | LEAY | T | 4+ | 2+ | 61 | | 1 | | |
| 02 | 2011 | | | | 32 | LEAS | ∀ | 4 + 4 + | 2+ | 62 | 0014 | ı | c . | ٠. |
| 03 | COM | | 6 | 2 | 33 | LEAU PSHS | Indexed | 4+ 5+ | 2+ | 63 64 | COM LSR | į | 6+ 6+ | 2+ 2+ |
| 04 05 | LSR | | 6 | 2 | 34 35 | PULS | Inherent | | 2 | 65 | • | 1 | 0+ | 2+ |
| | DOD | | • | 0 | | | T | 5+ | | | | 1 | c . | ٠. |
| 06 | ROR | | 6 | 2 | 36 | PSHU | 1 | 5+ | 2 | 66 | ROR | 1 | 6+ | 2+ 2+ |
| 07 | ASR | | 6 | 2 | 37 | PULU • | 1 | 5+ | 2 | 67 | ASR | 1 | 6+ | |
| 08 | ASL, LSL | | 6 | 2 | 38 | | 1 | _ | | 68 | ASL, LSL | 1 | 6+ | 2+ |
| 09 | ROL | | 6 | 2 | 39 | RTS | 1 | 5 | 1 | 69 | ROL | 1 | 6+ | 2+ |
| 0A | DEC | | 6 | 2 | 3A | ABX | 1 | 3 | 1 | 6A | DEC | | 6+ | 2+ |
| 0B | | | _ | _ | 3B | RTI | 1 | 6/15 | 1 | 6B | | 1 | ٠. | 2. |
| 0C | INC | ĺ | 6 | 2 | 3C | CWAI | 1 | ≥ 20 | 2 | 6C | INC | 1 | 6+ | 2+ |
| 0D | TST | i | 6 | 2 | 3D | MUL | 1 | 11 | 1 | 6D | TST | 1. | 6+ | 2+ |
| 0E | JMP | ₩ | 3 | 2 | 3E | • | 🗡 | | _ | 6E | JMP | ♥ | 3+ | 2+ |
| 0F | CLR | Direct | 6 | 2 | 3F | SWI | Inherent | 19 | 1 | 6F | CLR | Indexed | 6+ | 2+ |
| 10 | Page 2 | | _ | _ | 40 | NEGA | Inherent | 2 | 1 | 70 | NEG | Extended | 7 | 3 |
| 11 | Page 3 | | _ | - | 41 | • | A | | | 71 | • | • | | |
| 12 | NOP | Inherent | 2 | 1 | 42 | • | 1 | | | 72 | • | 1 | | |
| 13 | SYNC | Inherent | ≥4 | 1 | 43 | COMA | 1 | 2 | 1 | 73 | COM | | 7 | 3 |
| 14 | • | | | | 44 | LSRA | - 1 | 2 | 1 | 74 | LSR | j | 7 | 3 |
| 15 | • | | | | 45 | • | | | | 75 | • | 1 | | |
| 16 | LBRA | Relative | 5 | 3 | 46 | RORA | - 1 | 2 | 1 | 76 | ROR | 1 | 7 | 3 |
| 17 | LBSR | Relative | 9 | 3 | 47 | ASRA | 1 | 2 | 1 | 77 | ASR | - | 7 | 3 |
| 18 | • | | | | 48 | ASLA, LSLA | 1 | 2 | 1 | 78 | ASL, LSL | 1 | 7 | 3 |
| 19 | DAA | Inherent | 2 | 1 | 49 | ROLA | 1 | 2 | 1 | 79 | ROL | 1 | 7 | 3 |
| 1A | ORCC | Immed | 3 | 2 | 4A | DECA | } | 2 | 1 | 7 A | DEC | | 7 | 3 |
| 1B | • | - | | | 4B | • | 1 | | | 7B | • | 1 | | |
| 1C | ANDCC | Immed | 3 | 2 | 4C | INCA | 1 | 2 | 1 | 7C | INC | 1 | 7 | 3 |
| 1D | SEX | Inherent | 2 | 1 | 4D | TSTA | 1 | 2 | 1 | 7D | TST | l | 7 | 3 |
| 1E | EXG | • | 8 | 2 | 4E | • | ₩ | | | 7E | JMP | . ↓ | 4 | 3 |
| 1F | TFR | Inherent | 6 | 2 | 4F | CLRA | Inherent | 2 | 1 | 7F | CLR | Extended | 7 | 3 |
| 20 | BRA | Relative | 3 | 2 | 50 | NEGB | Inherent | 2 | 1 | 80 | SUBA | Immed | 2 | 2 |
| 21 | BRN | A | 3 | 2 | 51 | • | A | | | 81 | CMPA | A | 2 | 2 |
| 22 | вні | T | 3 | 2 | 52 | • | 1 | | | 82 | SBCA | 1 | 2 | 2 |
| 23 | BLS | 1 | 3 | 2 | 53 | COMB | | 2 | 1 | 83 | SUBD | 1 | 4 | 3 |
| 24 | BHS, BCC | | 3 | 2 | 54 | LSRB | } | 2 | 1 | 84 | ANDA | 1 | 2 | 2 |
| 25 | BLO, BCS | | 3 | 2 | 55 | • | } | | | 85 | BITA | 1 | 2 | 2 |
| 26 | BNE |) | 3 | 2 | 56 | RORB | | 2 | 1 | 86 | LDA | | 2 | 2 |
| 27 | BEQ | | 3 | 2 | 57 | ASRB | 1 | 2 | 1 | 87 | • | 1 | _ | _ |
| 28 | BVC | | 3 | 2 | 58 | ASLB, LSLB | 1 | 2 | 1 | 88 | EORA | 1 | 2 | 2 |
| 29 | BVS | 1 | 3 | 2 | 59 | ROLB | 1 | 2 | 1 | 89 | ADCA | | 2 | 2 |
| 2A | BPL | | 3 | 2 | 5A | DECB | | 2 | 1 | 8A | ORA | | 2 | 2 |
| 2B | BMI | | 3 | 2 | 5B | • | | - | ' | 8B | ADDA | 1 | 2 | 2 |
| 2C | BGE | ļ | 3 | 2 | 5C | INCB | | 2 | 1 | 8C | CMPX | Immed | 4 | 3 |
| 2D | BLT | | 3 | 2 | 5D | TSTB | | 2 | 1 | 8D | BSR | Relative | 7 | 2 |
| 2E | BGT | 1 | 3 | 2 | 5E | • | 1 | - | ' | 8E | LDX | Immed | 3 | 3 |
| 2F | BLE | Relative | 3 | 2 | 5F | CLRB | Inherent | 2 | 1 | 8F | * | minieu | 5 | 5 |
| 21 | DLL | Helative | J | 2 | 51 | OLIND | minerelli | _ | | OI. | | | | |

LEGEND

[~] Number of MPU cycles (less possible push pull or indexed-mode cycles)

[#] Number of program bytes

^{*} Denotes unused opcode

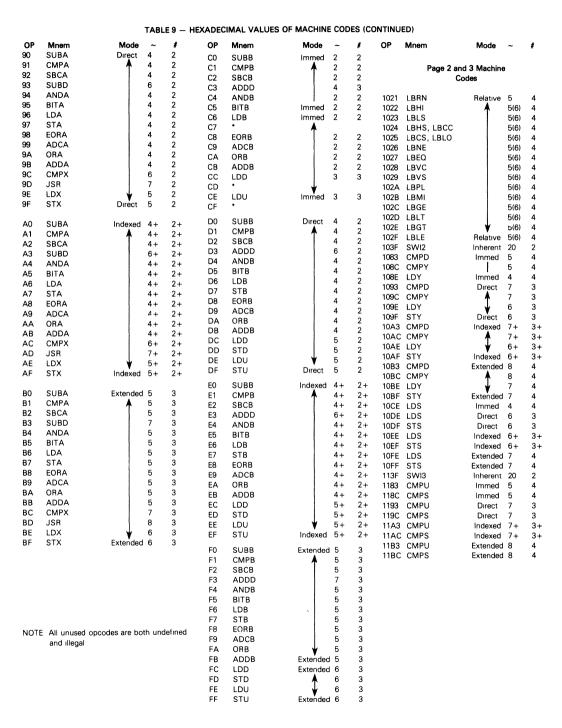


FIGURE 20 - PROGRAMMING AID

| | | | | | | | | | | | - PR | | | | | - | | | _ | | | |
|-------------|------------------------------|----------------------------|-------------|-------------|----------------------------|-------------|-------------|----------------------|--------------------------|----------------------|----------------------------|--|----------------|----------|-----------|------|--|-------------|--------------|-------------|--------|-------|
| | | | medi | | · · | Direc | | dress | | | | | | - | | | | | 3 | 2 | | 0 |
| Instruction | Forms | O _D | ~ | # | Op | ~ | 1 | Op | dexe | # | Op | ctend ~ | ea # | 00 | here ~ | nt # | Description | 5 H | | Z | V | č |
| ABX | | 1 | 1 | | - | _ | Ť | - | - | - | Up | | - | 3A | 3 | 1 | B+X→X (Unsigned) | • | • | • | • | • |
| ADC | ADCA ADCB | 89 C9 | 2 2 | 2 2 | 99 D9 | 4 | 2 2 | A9 E9 | 4+ | 2+ | B9 F9 | 5 | 3 | | | | A+M+C-A B+M+C-B | 1 | : | 1 | : | 1 |
| ADD | ADDA | 8B | 2 | 2 | 9B | 4 | 2 | AB | 4+ | 2+ | ВВ | 5 | 3 | | | _ | A+M-A | i | 1 | 1 | 1 | 1 |
| | ADDB | СВ | 2 | 2 | DB | 4 | 2 | EB | 4+ | 2+ | FB | 5 | 3 | | | | B+M→B | 1 | 1 | 1 | 1 | t |
| 4110 | ADDD | C3 | 4 | 3 | D3 | 6 | 2 | E3 | 6+ | 2+ | F3 | 7 | 3 | | | | D+M M+1-D | • | 1 | Ш | 1 | 1 |
| AND | ANDA ANDB ANDCC | 84 C4 1C | 2 2 3 | 2 2 2 | 94 D4 | 4 | 2 2 | E4 | 4+ 4+ | 2+ 2+ | B4 F4 | 5 5 | 3 | | | | A ∧ M → A B ∧ M → B CC ∧ IMM → CC | : | : | : | 0 | • 7 |
| ASL | ASLA ASLB ASL | | | | 08 | 6 | 2 | 68 | 6+ | 2+ | 78 | 7 | 3 | 48 58 | 2 2 | 1 | A B C D7 D0 | 8 8 8 | 1 1 | 1 1 | | 1 1 |
| ASR | ASRA ASRB ASR | | | | 07 | 6 | 2 | 67 | 6+ | 2+ | 77 | 7 | 3 | 47 57 | 2 2 | 1 | B → 1 → 1 → 1 | 8 8 | 1 | 1 | • | 1 1 |
| BIT | BITA BITB | 85 C5 | 2 2 | 2 2 | 95 D5 | 4 | 2 2 | A5 E5 | 4+ | 2+ | B5 F5 | 5 | 3 | | | | Bit Test A (M A A) Bit Test B (M A B) | : | 1 | : | 0 | • |
| CLR | CLRA CLRB | | | | | | | | | | | | | 4F 5F | 2 2 | 1 | 0-A 0-B | : | 0 0 | 1 | 0 | 0 |
| 0110 | CLR | - | _ | _ | 0F | 6 | 2 | 6F | 6+ | 2+ | 7F | 7 | 3 | L | _ | | 0-M | • | 0 | 11 | 0 | 0 |
| CMP | CMPA CMPB CMPD | 81 C1 10 83 | 2 2 5 | 2 2 4 | 91 D1 10 93 | 4 4 7 | 2 2 3 | A1 E1 10 A3 | 4+ 4+ 7+ | 2+ 2+ 3+ | B1 F1 10 B3 | 5 5 8 | 3 3 4 | | | | Compare M from A Compare M from B Compare M M + 1 from D | 8 | 1 1 | 1 1 1 | 1 | 1 1 |
| | CMPS | 11 8C | 5 | 4 | 11 9C | 7 | 3 | 11 AC | 7+ | 3+ | 11 BC | 8 | 4 | | | | Compare M M + 1 from S | • | ı | ı | 1 | 1 |
| | СМРИ | 11 83 | 5 | 4 | 11 93 | 7 | 3 | 11 A3 | 7+ | 3+ | 11 B3 | 8 | 4 | | | | Compare M M+1 from U | • | ı | 1 | 1 | 1 |
| | CMPX CMPY | 8C 10 8C | 4 5 | 3 4 | 9C 10 9C | 6 7 | 3 | AC 10 AC | 6+ 7+ | 2+ 3+ | BC 10 BC | 7 8 | 3 4 | | | | Compare M M + 1 from X Compare M M + 1 from Y | : | 1 | 1 | 1 | 1 |
| СОМ | COMA COMB COM | | | | 03 | 6 | 2 | 63 | 6+ | 2+ | 73 | 7 | 3 | 43 53 | 2 2 | 1 | A - A B - B M - M | : | 1 1 | 1 1 | 000 | 1 1 1 |
| CWAI | CON | 3C | ≥20 | 2 | - 03 | - | - | 03 | 0+ | 2+ | 1/3 | | 13 | | - | | CC ∧ IMM → CC Wait for Interrupt | ۲ | | H | - | 7 |
| DAA | | - | - | - | | | | | - | - | - | | | 19 | 2 | 1 | Decimal Adjust A | | ī | 1 | 0 | 1 |
| DEC | DECA DECB | | | | | | | | | | | | | 4A 5A | 2 2 | 1 | A – 1 – A B – 1 – B | : | i | 1 1 | - - | • |
| | DEC | | | | 0A | 6 | 2 | 6A | 6+ | 2+ | 7A | 7 | 3 | | | | M − 1 → M | • | 1 | 1 | 1 | • |
| EOR | EORA EORB | 88 C8 | 2 | 2 2 | 98 D8 | 4 | 2 2 | A8 E8 | 4 + 4 + | 2+ 2+ | B8 F8 | 5 5 | 3 3 | | | | A V M→A B V M→B | • | 1 | 1 | 0 | • |
| EXG | R1, R2 | | | | | | | | | | | | | 1E | 8 | 2 | R1 R2 ² | • | • | • | • | • |
| INC | INCA INCB INC | | | | 0C | ô | 2 | 6C | 6+ | 2+ | 7C | 7 | 3 | 4C 5C | 2 | 1 | A + 1 A B + 1 B M + 1 M | : | : | : | 1 1 | • |
| JMP | | _ | | | 0E | 3 | 2 | 6E | 3+ | 2+ | 7E | 4 | 3 | | | | EA ³ -PC | | ÷ | • | · | • |
| JSR | | | | | 9D | 7 | 2 | AD | 7+ | 2+ | BD | 8 | 3 | _ | | _ | Jump to Subroutine | • | • | • | • | • |
| LD | LDA | 86 | 2 | 2 | 96 | 4 | 2 | A6 | 4+ | 2+ | В6 | 5 | 3 | | | | M - A | • | 1 | ı | 0 | • |
| | LDB LDD LDS | C6 CC 10 | 3 4 | 2 3 4 | D6 DC 10 | 4 5 6 | 2 2 3 | E6 EC 10 | 4+ 5+ 6+ | 2+ 2+ 3+ | F6 FC 10 | 5 6 7 | 3 3 4 | | | | M→B M M+1→D M M+1→S | : | 1 | 1 1 1 | 0 0 | • |
| | LDU LDX LDY | CE CE 8E 10 8E | 3 3 4 | 3 3 4 | DE DE 9E 10 9E | 5 5 6 | 2 2 3 | EE EE AE 10 | 5+ 5+ 6+ | 2+ 2+ 3+ | FE FE BE 10 BE | 6 6 7 | 3 3 4 | | | | M M + 1 → U M M + 1 → X M M + 1 → Y | : | 1 1 | 1 1 1 | 0 0 0 | : |
| LEA | LEAS LEAU LEAX LEAY | ÖE. | | | 9E | | | 32 33 30 31 | 4 + 4 + 4 + 4 + | 2+ 2+ 2+ 2+ | BE | | | | | | EA ³ – S EA ³ – U EA ³ – X EA ³ – Y | • • • • | • | • • • • | • | • |

Legend

- OP Operation Code (Hexadecimal)
- Number of MPU Cycles
- # Number of Program Bytes
- + Arithmetic Plus
- Arithmetic Minus
- Multiply

- M Complement of M
 - Transfer Into
- H Half-carry (from bit 3)
- N Negative (sign bit)
- Z Zero result
- V Overflow, 2's complement
- C Carry from ALU

- t Test and set if true, cleared otherwise
- Not Affected
- CC Condition Code Register
- . Concatenation
- V Logical or
- Λ Logical and
- → Logical Exclusive or

FIGURE 20 - PROGRAMMING AID (CONTINUED)

| | · | Γ | | | | | Ad | dressi | ng N | lodes | | | | | | | | Π | Γ | | | |
|-------------|--------------------------|----------------|-------------|-------|----------------------------|-------------|---------|----------------------------|----------------------|----------------------|----------------------|------------------|-------------|----------------|----------|-----|--|-------------|---|--------------|-------------|-----|
| | | | media | ite | | Direc | | In | dexe | | | tend | ed | Ir | here | nt | | 5 | | 2 | | 0 |
| Instruction | Forms | Op | ~ | * | Ор | ~ | # | Op | ~ | # | Ор | ~ | # | Op | ~ | # | Description | Н | N | Z | ٧ | С |
| LSL | LSLA LSLB LSL | | | | 08 | 6 | 2 | 68 | 6+ | 2+ | 78 | 7 | 3 | 48 58 | 2 2 | 1 | A B C b7 b0 | | : : | 1 1 1 | 1 1 | 1 1 |
| LSR | LSRA LSRB LSR | | | | 04 | 6 | 2 | 64 | 6+ | 2+ | 74 | 7 | 3 | 44 54 | 2 2 | 1 | A B M O → □ □ □ □ □ □ □ □ □ □ □ □ □ □ □ □ □ □ | : | 0 0 0 | 1 1 | • | 1 1 |
| MUL | | | | | | | | | | | | | | 3D | 11 | 1 | A × B → D (Unsigned) | • | • | 1 | • | 9 |
| NEG | NEGA NEGB NEG | | | | 00 | 6 | 2 | 60 | 6+ | 2+ | 70 | 7 | 3 | 40 50 | 2 | 1 | Ā+1→A B+1→B M+1→M | 8 8 8 | 1 1 | 1 1 | 1 1 1 | 1 1 |
| NOP | | | | | | | | | | | | | | 12 | 2 | 1 | No Operation | • | • | • | • | • |
| OR | ORA ORB ORCC | 8A CA 1A | 2 2 3 | 2 2 2 | 9A DA | 4 | 2 | AA EA | 4 + 4 + | 2+ 2+ | BA FA | 5 | 3 | | | | A ∨ M → A B ∨ M → B CC ∨ IMM → CC | : | 1 | 1 | 0 0 7 | • |
| PSH | PSHS PSHU | | 5+4 5+4 | 2 | | | | | | | | | | | | | Push Registers on S Stack Push Registers on U Stack | : | : | : | • | • |
| PUL | PULS PULU | 35 37 | 5+4 5+4 | 2 | | | | | | | | | | | | | Pull Registers from S Stack Pull Registers from U Stack | : | : | : | : | : |
| ROL | ROLA ROLB ROL | | | | 09 | 6 | 2 | 69 | 6+ | 2+ | 79 | 7 | 3 | 49 59 | 2 | 1 | A B B C D7 D0 | : | 1 1 | ! ! | 1 1 1 | 1 1 |
| ROR | RORA RORB ROR | | | | 06 | 6 | 2 | 66 | 6+ | 2+ | 76 | 7 | 3 | 46 56 | 2 2 | 1 | A B M C b ₇ b ₀ | : | 1 1 | 1 1' 1 | : | 1 1 |
| RTI | | | | | | | | | | | | | | 3B | 6/15 | 1 | Return From Interrupt | Π | Г | | П | 7 |
| RTS | | | | | | | | | | | | | | 39 | 5 | 1 | Return from Subroutine | • | • | • | • | • |
| SBC | SBCA SBCB | 82 C2 | 2 2 | 2 2 | 92 D2 | 4 | 2 2 | A2 E2 | 4 + 4 + | 2+ 2+ | B2 F2 | 5 5 | 3 | | | | A - M - C → A B - M - C → B | 8 8 | : | 1 | 1 | 1 |
| SEX | | | | | | | | | | | | | | 1D | 2 | 1 | Sign Extend B into A | • | 1 | ı | 0 | • |
| ST | STA STB STD STS | | | | 97 D7 DD 10 DF | 4 5 6 | 2 2 2 3 | A7 E7 ED 10 EF | 4+ 4+ 5+ 6+ | 2+ 2+ 2+ 3+ | F7 FD 10 FF | 5 5 6 7 | 3 3 4 | | | | A - M B - M D - M M + 1 S - M M + 1 | | ::::::::::::::::::::::::::::::::::::::: | : | 0000 | • |
| | STU STX STY | | | | DF 9F 10 9F | 5 5 6 | 2 2 3 | AF 10 AF | 5+ 5+ 6+ | 2+ 2+ 3+ | FF BF 10 BF | 6 6 7 | 3 3 4 | | | | U-M M+1 X-M M+1 Y-M M+1 | : | : | 1 1 | 0 | |
| SUB | SUBA SUBB SUBD | 80 C0 83 | 2 2 4 | 2 2 3 | 90 D0 93 | 4 4 6 | 2 2 2 | A0 E0 A3 | 4+ 4+ 6+ | 2+ 2+ 2+ | B0 F0 B3 | 5 5 7 | 3 3 3 | | | | A – M → A B – M → B D – M M + 1 → D | 8 8 • | 1 1 | 1 1 | 1 1 | 1 1 |
| SWI | SWI ⁶ | | | | | | | | | | | | | 3F 10 3F | 19 20 | 1 2 | Software Interrupt 1 Software Interrupt 2 | : | : | • | • | • |
| | swi ⁶ | | | | | | | | | | | | | 11 3F | 20 | 1 | Software Interrupt 3 | • | • | • | • | • |
| SYNC | | | | | | | | | | | | | | 13 | ≥4 | 1 | Synchronize to Interrupt | • | • | • | • | • |
| TFR | R1, R2 | _ | | _ | L | | | | | | | _ | | 1F | 6 | 2 | R1 → R2 ² | | • | • | • | • |
| TST | TSTA TSTB TST | | | | 0D | 6 | 2 | 6D | 6+ | 2+ | 7D | 7 | 3 | 4D 5D | 2 2 | 1 | Test A Test B Test M | | 1 1 | : | 0 0 | |

Notes

- This column gives a base cycle and byte count. To obtain total count, add the values obtained from the INDEXED ADDRESSING MODE table, Table 2
- 2. R1 and R2 may be any pair of 8 bit or any pair of 16 bit registers
 - The 8 bit registers are A, B, CC, DP
 - The 16 bit registers are X, Y, U, S, D, PC
- 3 EA is the effective address
- 4. The PSH and PUL instructions require 5 cycles plus 1 cycle for each byte pushed or pulled
- 5. 5(6) means 5 cycles if branch not taken, 6 cycles if taken (Branch instructions)
- 6 SWI sets I and F bits SWI2 and SWI3 do not affect I and F
- 7 Conditions Codes set as a direct result of the instruction
- 8 Vaue of half-carry flag is undefined
- 9. Special Case Carry set if b7 is SET

FIGURE 20 - PROGRAMMING AID (CONTINUED)

Branch Instructions

| | | | Idress Mode | , | | | | | | |
|-------------|-------------|----------------|----------------|--------|---|--------|--------|--------|---|---|
| Instruction | Forms | OP | elativ | | Description | 5 H | 3 N | 2 Z | 1 | 0 |
| BCC | BCC LBCC | 24 10 24 | 3 5(6) | 2 4 | Branch C=0 Long Branch C=0 | : | : | : | : | : |
| BCS | BCS LBCS | 25 10 25 | 3 5(6) | 4 | Branch C = 1 Long Branch C = 1 | : | : | • | : | : |
| BEQ | BEQ LBEQ | 27 10 27 | 3 5(6) | 2 4 | Branch Z= 1 Long Branch Z=0 | : | : | • • | : | : |
| BGE | BGE LBGE | 2C 10 2C | 3 5(6) | 2 4 | Branch≥Zero Long Branch≥Zero | : | : | • | : | : |
| BGT | BGT LBGT | 2E 10 2E | 3 5(6) | 2 4 | Branch > Zero Long Branch > Zero | : | : | • | : | • |
| ВНІ | BHI LBHI | 22 10 22 | 3 5(6) | 2 4 | Branch Higher Long Branch Higher | : | : | • • | : | • |
| BHS | BHS LBHS | 24 10 24 | 3 5(6) | 4 | Branch Higher or Same Long Branch Higher or Same | | • | | • | • |
| BLE | BLE LBLE | 2F 10 2F | 3 5(6) | 2 4 | Branch≤Zero Long Branch≤Zero | : | • | : | • | : |
| BLO | BLO LBLO | 25 10 25 | 3 5(6) | 4 | Branch lower Long Branch Lower | • | • | • | • | • |

| | | | | _ | | | | | Mode | | | | | | | |
|-----|-----|-----|----------|---------|-----------|-----------------------|-------------------------------|---------------------------------|---------------------------------------|-------------------|--|-------------------|-------------------|-------------------|-------------------|---------------------------------------|
| | | | - | | Ine | truction | Forms | | | | Description | | | | | O C |
| - | | ٠ | ÷ | ÷ | - | | | | | _ | | - | - | - | _ | ř |
| | | | | | | | BLJ | 23 | 3 | _ | | ľ | • | | ľ | ľ |
| | | | | | | | LBLS | 10 | 5(6) | 4 | Long Branch Lower | • | • | • | | |
| | • | • | | • | 1 | | | 23 | | | or Same | | | ١. | | Į |
| • | | | | | BLT | | BLT | 2D | 3 | 2 | Branch < Zero | • | • | • | • | • |
| | | | | | | - 1 | LBLT | 10 | 5(6) | 4 | Long Branch < Zero | • | • | • | • | • |
| • | • | • | | • | | | | 2D | | | | 1 | | | | |
| • | • | • | • | • | BMI | | ВМІ | 2B | 3 | 2 | Branch Minus | • | • | • | • | • |
| | | | | | | 1 | LBMI | 10 | 5(6) | 4 | Long Branch Minus | • | • | • | ٠ | • |
| • | • | • | • | • | | | | 2B | | | | | | L | L | L |
| • | • | • | • | • | BNE | .] | BNE | 26 | 3 | 2 | | • | • | • | • | • |
| | | | | | 1 | | LBNE | | 5(6) | 4 | | ٠ | • | • | • | • |
| • | • | • | • | • | | | | - | | | | | | | _ | _ |
| • | • | • | • | • | BPL | i | | | | | | • | • | • | • | • |
| | | | L | | | | LBPL | | 5(6) | 4 | Long Branch Plus | • | ٠ | • | • | ٠ |
| • | • | • | • | • | L | | | - | | | | _ | | _ | _ | _ |
| • | • | • | • | • | BRA | ٠ | | | | | | 1 | • | • | ٠. | • |
| _ | L., | _ | L | | L | | | | | | | \vdash | • | • | Ŀ | • |
| • | • | • | • | • | BRN | | | | | | | 1 1 | • | • | • | • |
| ĺ | | | | | | 1 | LBRN | | 5 | 4 | Long Branch Never | • | • | • | • | • |
| • | • | • | ٠. | • | l | | | - | | | | Н | | | <u> </u> | ⊢ |
| ⊢ | _ | | <u> </u> | | BSR | | | | | | | • | • | • | • | • |
| • | • | • | • | • | 1 | 1 | LR2H | 17 | 9 | 3 | | • | • | • | ٠ | • |
| • | • | • | ٠. | • | l | | | - | | | | Н | | _ | _ | _ |
| - | - | Ļ | <u> </u> | _ | BAC | | | | | _ | | 1 1 | • | • | | • |
| 1 . | : | • | : | : | | | FRAC | | 5(6) | 4 | | • | • | • | • | • |
| Ī | • | • | • | • | 1 | | D) (C | | | - | | - | | μ. | <u> </u> | H |
| | | | | | BVS | 1 | | | | | | • | • | | | • |
| ١. | | ١. | | | | | LDVS | 29 | 2(0) | 4 | V = 1 | • | • | • | ١. | • |
| | • | H N | H N Z | H N Z V | H N Z V C | H N Z V C Ins BLS | H N Z V C Instruction BLS | H N Z V C Instruction Forms | S S S S S S S S S S | S 3 2 1 0 | H N Z V C Section Forms OP 5 F | S 3 2 1 0 | S 3 2 1 0 | S 3 2 1 0 | S 3 2 1 0 | S S S S S S S S S S |

SIMPLE BRANCHES

| | OP | ~ | # |
|------|------|---|---|
| BRA | 20 | 3 | 2 |
| LBRA | 16 | 5 | 3 |
| BRN | 21 | 3 | 2 |
| LBRN | 1021 | 5 | 4 |
| BSR | 8D | 7 | 2 |
| LBSR | 17 - | 9 | 3 |

SIMPLE CONDITIONAL BRANCHES (Notes 1-4)

| CHAIR ELE CONDITIONAL BITTANGILES (NOTOS 1 4) | | | | |
|---|------|----|-------|----|
| Test | True | OP | False | OP |
| N = 1 | BMI | 2B | BPL | 2A |
| Z = 1 | BEQ | 27 | BNE | 26 |
| V = 1 | BVS | 29 | BVC | 28 |
| C = 1 | BCS | 25 | BCC | 24 |

SIGNED CONDITIONAL BRANCHES (Notes 1-4)

| Test | True | OP | False | OP |
|-------|------|----|-------|----|
| r>m | BGT | 2E | BLE | 2F |
| r≥m | BGE | 2C | BLT | 2D |
| r = m | BEQ | 27 | BNE | 26 |
| r≤m | BLE | 2F | BGT | 2E |
| r < m | BLT | 2D | BGE | 2C |

UNSIGNED CONDITIONAL BRANCHES (Notes 1-4)

| Test | True | OP | False | OP |
|---|------|----|-------|----|
| r>m | вні | 22 | BLS | 23 |
| r≥m | BHS | 24 | BLO | 25 |
| r = m | BEQ | 27 | BNE | 26 |
| r≤m | BLS | 23 | вні | 22 |
| r <m< td=""><td>BLO</td><td>25</td><td>BHS</td><td>24</td></m<> | BLO | 25 | BHS | 24 |

Notes

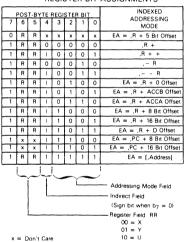
- 1 All conditional branches have both short and long variations
- 2 All short branches are 2 bytes and require 3 cycles
- 3 All conditional long branches are formed by prefixing the short branch opcode with \$10 and using a 16-bit destination offset
- 4 All conditional long branches require 4 bytes and 6 cycles if the branch is taken or 5 cycles if the branch is not taken
- 5 5(6) means 5 cycles if branch not taken, 6 cycles if taken

INDEXED ADDRESSING MODES

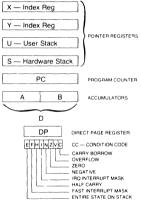
| | | NON INDIRECT | | | | INDIRECT | | | |
|----------------------------|---|-----------------------------|--|---|-------|----------------------------|---|---|-----|
| TYPE | FORMS | Assembler Form | Post-Byte OP Code | + | + # | Assembler Form | Post-Byte OP Code | + | + |
| CONSTANT OFFSET FROM R | NO OFFSET 5 BIT OFFSET 8 BIT OFFSET 16 BIT OFFSET | , R n, R n, R n, R | 1RR00100 0RRnnnn 1RR01000 1RR01001 | 1 | | | 1RR10100 ults to 8-bit 1RR11000 1RR11001 | 4 | 1 |
| ACCUMULATOR OFFSET FROM R | A—REGISTER OFFSET B—REGISTER OFFSET D—REGISTER OFFSET | A, R B, R D, R | 1RR00110 1RR00101 1RR01011 | 1 | 0 0 0 | [A, R] [B, R] [D, R] | 1RR10110 1RR10101 1RR11011 | | 000 |
| AUTO INCREMENT/DECREMENT R | INCREMENT BY 1 INCREMENT BY 2 DECREMENT BY 1 DECREMENT BY 2 | , R+ , R++ , -R ,R | 1RR00000 1RR00001 1RR00010 1RR00011 | 3 | 0 | [, R++] no | t allowed 1RR10001 t allowed 1RR10011 | | |
| CONSTANT OFFSET FROM PC | 8 BIT OFFSET | n, PCR | 1XX01100 | | 1 | [n, PCR] | 1XX11100 | | |
| EXTENDED INDIRECT | 16 BIT ADDRESS | _ | _ | Ē | Ē | [n] | | | 2 |

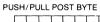
R = X, Y, U, or SX = DON'T CARE RR: 00 = X 10 = U 01 = Y 11 = S

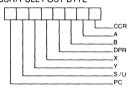
INDEXED ADDRESSING POSTBYTE REGISTER BIT ASSIGNMENTS











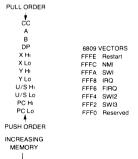
TRANSFER/EXCHANGE POST BYTE

| | T T T |
|--------|-------------|
| SOURCE | DESTINATION |

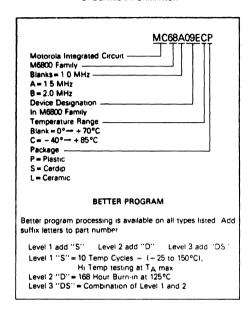
REGISTER FIELD

| 0000 | D (A B) | 1000 - | Α |
|------|---------|--------|-----|
| 0001 | × | 1001 | В |
| 0010 | Υ | 1010 | CCR |
| 0011 | U | 1011 | DPR |
| 0100 | S | | |
| 0101 | PC | | |
| | | | |

6809 STACKING ORDER



ORDERING INFORMATION



| Speed | Device | Temperature Range |
|---------|---------------|-------------------|
| 1.0 MHz | MC6809EP,L,S | 0 to 70°C |
| 1 5 MHz | MC68A09EP,L,S | 0 to +70°C |
| 2 0 MHz | MC68B09EP,L,S | 0 to +70°C |



128×8-BIT STATIC RANDOM ACCESS MEMORY

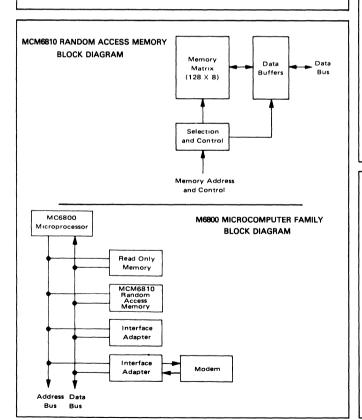
The MCM6810 is a byte-organized memory designed for use in busorganized systems. It is fabricated with N-channel silicon-gate technology. For ease of use, the device operates from a single power supply, has compatibility with TTL and DTL, and needs no clocks or refreshing because of static operation.

The memory is compatible with the M6800 Microcomputer Family, providing random storage in byte increments. Memory expansion is provided through multiple Chip Select inputs

- Organized as 128 Bytes of 8 Bits
- Static Operation
- Bidirectional Three-State Data Input/Output
- Six Chip Select Inputs (Four Active Low, Two Active High)
- Single 5-Volt Power Supply
- TTL Compatible
- Maximum Access Time = 450 ns MCM6810

360 ns - MCM68A10

250 ns - MCM68B10

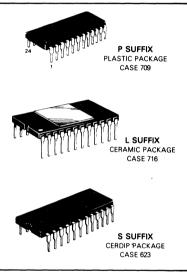


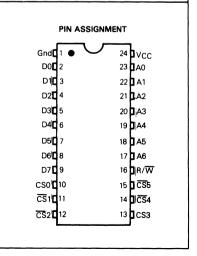
MCM6810 (1.0 MHz) MCM68A10 (1.5 MHz) MCM68B10 (2.0 MHz)

MOS

(N-CHANNEL, SILICON-GATE)

128×8-BIT STATIC RANDOM ACCESS MEMORY





(2)

MCM6810 • MCM68A10 • MCM68B10

MAXIMUM RATINGS

| Rating | Symbol | Value | Unit |
|---|------------------|--|------|
| Supply Voltage | Vcc | -0.3 to +7.0 | V |
| Input Voltage | V _{in} | -0.3 to +7.0 | V |
| Operating Temperature Range MCM6810, MCM68A10, MCM68B10 MCM6810C, MCM68A10C | TA | T _L to T _H 0 to +70 -40 to +85 | °C |
| Storage Temperature Range | T _{stg} | -65 to +150 | °C |

This device contains circuitry to protect the inputs against damage due to high static voltages or electric fields, however, it is advised that normal precautions be taken to avoid application of any voltage higher than maximum rated voltages to this high impedance circuit. Reliability of operation is enhanced if unused inputs are tied to an appropriate logic voltage (e.g., either VSS or VCC).

THERMAL CHARACTERISTICS

| Characteristics | Symbol | Value | Unit |
|--------------------|--------------|-------|------|
| Thermal Resistance | | | |
| Ceramic |] | 60 | j |
| Plastic | ₀ | 120 | °C/W |
| Cerdip | " | 65 | 1 |

POWER CONSIDERATIONS

The average chip-junction temperature, TJ, in °C can be obtained from:

$$T_{J} = T_{A} + (P_{D} \theta_{JA}) \tag{1}$$

Where:

T_A = Ambient Temperature, °C

θJA = Package Thermal Resistance, Junction-to-Ambient, °C/W

PD = PINT + PPORT

PINT≡ICC×VCC, Watts — Chip Internal Power

PPORT ■ Port Power Dissipation, Watts — User Determined

For most applications PPORT ◆PINT and can be neglected PPORT may become significant if the device is configured to drive Darlington bases or sink LED loads

An approximate relationship between PD and TJ (if PPORT is neglected) is:

$$P_D = K + (T_J + 273 ^{\circ}C)$$

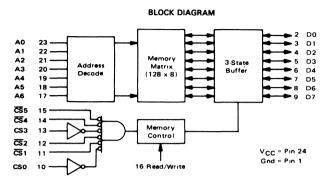
Solving equations 1 and 2 for K gives.

$$K = P_D \bullet (T_A + 273 \circ C) + \theta_{JA} \bullet P_D^2$$

Where K is a constant pertaining to the particular part. K can be determined from equation 3 by measuring PD (at equilibrium) for a known TA. Using this value of K the values of PD and TJ can be obtained by solving equations (1) and (2) iteratively for any value of TA.

DC ELECTRICAL CHARACTERISTICS (V_{CC}=5 0 Vdc ±5%, V_{SS}=0, T_A=T_L to T_H unless otherwise noted)

| Characteristic | | Symbol | Min | Max | Unit |
|---|--------------|-----------------|---------------------|---------------------|------|
| Input High Voltage | | ViH | V _{SS} +20 | Vcc | V |
| Input Low Voltage | | VIL | V _{SS} -03 | V _{SS} +08 | V |
| Input Current (A _n , R/ \overline{W} , \overline{CS}_n) (V _{In} = 0 to 5.25 V) | | I _{In} | _ | 2 5 | μΑ |
| Output High Voltage (I _{OH} = -205 μA) | | ∨он | 2 4 | - 1 | V |
| Output Low Voltage (IOL = 1 6 mA) | | VOL | | 04 | V |
| Output Leakage Current (Three-State) (CS = 0.8 V or $\overline{\text{CS}}$ = 2 0 V, V _{out} = 0.4 V | / to 2 4 V) | İTSI | _ | 10 | μА |
| Supply Current | 1.0 MHz | | - | 80 | mA |
| $(V_{CC} = 5.25 \text{ V}, \text{ All Other Pins Grounded})$ Input Capacitance $(A_n, R/\overline{W}, CS_n, \overline{CS}_n)$ $(V_{In} = 0, T_A = 25^{\circ}C, f = 1.0 \text{ MHz})$ | 1 5, 2.0 MHz | C _{in} | | 7 5 | pF |
| Output Capacitance (Dn) (Vout=0, TA=25°C, f=1 0 MHz, CSO=0) | | Cout | | 12 5 | pF |



AC OPERATING CONDITIONS AND CHARACTERISTICS

READ CYCLE ($V_{CC} = 5.0 \text{ V} \pm 5\%$, $V_{SS} = 0$, $T_A = T_L$ to T_H unless otherwise noted)

| | | MCM6810 | | MCM68A10 | | MCM68B10 | | |
|----------------------------|---------------------|---------|-----|----------|-----|----------|-----|------|
| Characteristic | Symbol | Min | Max | Min | Max | Min | Max | Unit |
| Read Cycle Time | t _{cyc(R)} | 450 | | 360 | _ | 250 | _ | ns |
| Access Time | tacc | _ | 450 | - | 360 | - | 250 | ns |
| Address Setup Time | †AS | 20 | _ | 20 | _ | 20 | _ | ns |
| Address Hold Time | ^t AH | 0 | _ | 0 | _ | 0 | _ | ns |
| Data Delay Time (Read) | †DDR | _ | 230 | - | 220 | - | 180 | ns |
| Read to Select Delay Time | tRCS | 0 | _ | 0 | _ | 0 | _ | ns |
| Data Hold from Address | tDHA | 10 | - | 10 | _ | 10 | _ | ns |
| Output Hold Time | tн | 10 | - | 10 | - | 10 | _ | ns |
| Data Hold from Read | ^t DHR | 10 | 80 | 10 | 60 | 10 | 60 | ns |
| Read Hold from Chip Select | t _{RH} | 0 | T - | 0 | _ | 0 | | ns |

READ CYCLE TIMING - tcyc(R)-Address ^tAH ^tDDR cs t BH tRCS Data Out -Data Valid

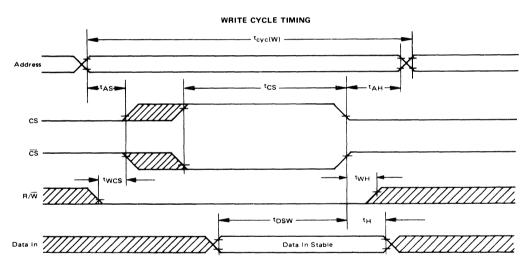
NOTES

- 1 Voltage levels shown are V_L≤0 4 V, V_H≥2 4 V, unless otherwise specified 2 Measurement points shown are 0 8 V and 2 0 V, unless otherwise specified
- 3 CS and CS have same timing



WRITE CYCLE (V_{CC} = 5 0 V \pm 5%, V_{SS} = 0, T_A = T_L to T_H unless otherwise noted)

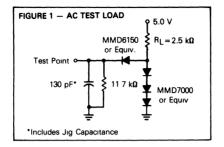
| | | MCM6810 | | MCM68A10 | | MCM68B10 | | |
|----------------------------------|------------------|---------|-----|----------|-----|----------|-----|------|
| Characteristic | Symbol | Min | Max | Min | Max | Min | Max | Unit |
| Write Cycle Time | tcyc(W) | 450 | _ | 360 | _ | 250 | _ | ns |
| Address Setup Time | t _{AS} | 20 | | 20 | _ | 20 | - | ns |
| Address Hold Time | ^t AH | 0 | - | 0 | _ | 0 | _ | ns |
| Chip Select Pulse Width | tcs | 300 | _ | 250 | _ | 210 | - | ns |
| Write to Chip Select Delay Time | twcs | 0 | _ | 0 | _ | 0 | _ | ns |
| Data Setup Time (Write) | ^t DSW | 190 | - | 80 | - | 60 | | ns |
| Input Hold Time | tH | 10 | - | 10 | - | 10 | - | ns |
| Write Hold Time from Chip Select | twH | 0 | - | 0 | - | 0 | - | ns |



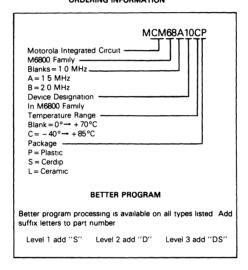
NOTES

- 1 Voltage levels shown are V_L \leq 0 4 V, V_H \geq 2 4 V, unless otherwise specified 2 Measurement points shown are 0 8 V and 2 0 V, unless otherwise specified 3 CS and $\overline{\text{CS}}$ have same timing





ORDERING INFORMATION



Level 1 "S" = 10 Temp Cycles - (- 25 to 150°C), Hi Temp testing at T $_{\Delta}$ max Level 2 "D" = 168 Hour Burn-in at 125°C Level 3 "DS" = Combination of Level 1 and 2

| Speed | Device | Temperature Range |
|---------|-----------------------------------|----------------------------|
| 1.0 MHz | MCM6810P,L,S MCM6810CP,CL,CS | 0 to +70°C -40 to +85°C |
| 1.5 MHz | MCM68A10P,L,S MCM68A10CP,CL,CS | 0 to +70°C -40 to +85°C |
| 2.0 MHz | MCM68B10P,L,S | 0 to +70°C |



MC6821 (1.0 MHz) MC68A21 (1.5 MHz) MC68B21 (2.0 MHz)

PERIPHERAL INTERFACE ADAPTER (PIA)

The MC6821 Peripheral Interface Adapter provides the universal means of interfacing peripheral equipment to the M680C family of microprocessors. This device is capable of interfacing the MPU to peripherals through two 8-bit undirectional peripheral data buses and four control lines. No external logic is required for interfacing to most peripheral devices.

The functional configuration of the PIA is programmed by the MPU during system initialization. Each of the peripheral data lines can be programmed to act as an input or output, and each of the four control/interrupt lines may be programmed for one of several control modes. This allows a high degree of flexibility in the overall operation of the interface.

- 8-Bit Bidirectional Data Bus for Communication with the MPU
- Two Bidirectional 8-Bit Buses for Interface to Peripherals
- Two Programmable Control Registers
- Two Programmable Data Direction Registers
- Four Individually-Controlled Interrupt Input Lines, Two Usable as Peripheral Control Outputs
- Handshake Control Logic for Input and Output Peripheral Operation
- High-Impedance Three-State and Direct Transistor Drive Peripheral Lines
- Program Controlled Interrupt and Interrupt Disable Capability
- CMOS Drive Capability on Side A Peripheral Lines
- Two TTL Drive Capability on All A and B Side Buffers
- TTL-Compatible
- Static Operation

MAXIMUM RATINGS

| Characteristics | Symbol | Value | Unit |
|--|------------------|---|------|
| Supply Voltage | Vcc | -03 to +70 | ٧ |
| Input Voltage | V _{in} | -0.3 to +7.0 | ٧ |
| Operating Temperature Range MC6821, MC68A21, MC68B21 MC6821C, MC68A21C, MC68B21C | ТА | T _L to T _H 0 to 70 -40 to +85 | °C |
| Storage Temperature Range | T _{stg} | -55 to +150 | °C |

THERMAL CHARACTERISTICS

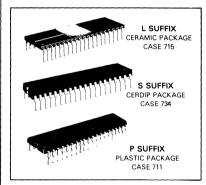
| Characteristic | Symbol | Value | Unit |
|---|--------|-----------------|------|
| Thermal Resistance Ceramic Plastic Cerdip | θJA | 50 100 60 | °C/W |

This device contains circuitry to protect the inputs against damage due to high static voltages or electric fields, however, it is advised that normal precautions be taken to avoid application of any voltage higher than maximum-rated voltages to this high-impedance circuit. Reliability of operation is enhanced if unused inputs are tied to an appropriate logic voltage (i.e., either VSS or VCC).

MOS

(N-CHANNEL, SILICON-GATE, DEPLETION LOAD)

PERIPHERAL INTERFACE ADAPTER



PIN ASSIGNMENT

| | | | ~ |
|--------------------------|-----|----|--------------|
| ٧ss [| 1 • | 40 | CA1 |
| PA0 | 2 | 39 | CA2 |
| PA1 [| 3 | 38 | IRQA |
| PA2 | 4 | 37 | IRQB |
| PA3 [| 5 | 36 | I RS0 |
| PA4 | 6 | 35 | IRS1 |
| PA5 [| 7 | 34 | RESET |
| PA6 [| 8 | 33 | 1 00 |
| PA7 [| 9 | 32 | D D1 |
| РВ0 [| 10 | 31 | D D2 |
| PB1 [| 11 | 30 | D D3 |
| PB2 [| 12 | 29 | 1 D4 |
| РВ3 [| 13 | 28 | D D5 |
| PB4 ∫ | 14 | 27 | D 6 |
| PB5 ∙[| 15 | 26 | D 7 |
| РВ6 [| 16 | 25 | Di∈ |
| РВ7 [| 17 | 24 | CS1 |
| CB1 [| 18 | 23 | CS2 |
| CB2 [| 19 | 22 | cso |
| v _{CC} t | 20 | 21 | P R/₩ |
| , | | | , |

POWER CONSIDERATIONS

The average chip-junction temperature, TJ, in ${}^{\circ}\text{C}$ can be obtained from

$$T_{i,j} = T_{i,j} + (P_{i,j} - \theta_{i,j} - \theta_{i,j})$$

Where

TA = Ambient Temperature, °C

 $\theta_{JA} \equiv Package Thermal Resistance, Junction-to-Ambient, °C/W$

PD = PINT + PPORT

 $PINT \equiv ICC \times VCC$, Watts - Chip Internal Power

PPORT = Port Power Dissipation, Watts - User Determined

 $\vec{\text{For most applications PPORT}} \blacktriangleleft \vec{\text{PINT}} \text{ and can be neglected} \quad \vec{\text{PPORT}} \text{ may become significant if the device is configured to drive Darlington bases or sink LED loads}$

An approximate relationship between P_D and T_J (if P_{PORT} is neglected) is

 $P_D = K - (T_J + 273 ^{\circ}C)$

(2)

(1)

Solving equations 1 and 2 for K gives

 $K = PD \bullet (TA + 273 \circ C) + \theta JA \bullet PD^2$

(3)

Where K is a constant pertaining to the particular part. K can be determined from equation 3 by measuring PD (at equilibrium) for a known TA. Using this value of K the values of PD and TJ can be obtained by solving equations (1) and (2) iteratively for any value of TA.

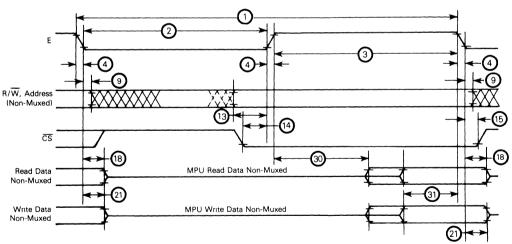
DC ELECTRICAL CHARACTERISTICS ($V_{CC} = 5.0 \text{ Vdc } \pm 5\%$, $V_{SS} = 0$, $T_A = T_L$ to T_H unless otherwise noted)

| Characteristic | Symbol | Min | Тур | Max | Unit |
|--|-----------------|---------------------|-------|---------------------|----------|
| BUS CONTROL INPUTS (R/W, Enable, RESET, RS0, RS1, CS0, CS1, CS2) | | | | | |
| Input High Voltage | VIH | V _{SS} +20 | | Vcc | V |
| Input Low Voltage | VIL | V _{SS} -03 | _ | V _{SS} +08 | V |
| Input Leakage Current (V _{In} = 0 to 5 25 V) | I _{In} | _ | 10 | 25 | μA |
| Capacitance (V _{IN} = 0, T _A = 25°C, f = 1 0 MHz) | C _{in} | _ | _ | 7 5 | pF |
| INTERRUPT OUTPUTS (IRQA, IRQB) | | | | | |
| Output Low Voltage (I _{Load} = 3 2 mA) | VOL | - | _ | V _{SS} +04 | V |
| Three-State Output Leakage Current | loz | - | 10 | 10 | μΑ |
| Capacitance (V _{In} = 0, T _A = 25°C, f = 1 0 MHz) | Cout | - | _ | 50 | рF |
| DATA BUS (D0-D7) | | | | | |
| Input High Voltage | VIH | V _{SS} +20 | _ | VCC | V |
| Input Low Voltage | VIL | V _{SS} -03 | _ | V _{SS} +08 | V |
| Three-State Input Leakage Current (V _{In} = 0 4 to 2 4 V) | ΙΙΖ | _ | 20 | 10 | μΑ |
| Output High Voltage ($I_{Load} = -205 \mu A$) | Vон | V _{SS} +24 | _ | - | V |
| Output Low Voltage (I _{Load} = 1 6 mA) | VOL | - | _ | V _{SS} +04 | V |
| Capacitance (V _{In} = 0, T _A = 25°C, f = 1 0 MHz) | C _{in} | - | | 12 5 | рF |
| PERIPHERAL BUS (PA0-PA7, PB0-PB7, CA1, CA2, CB1, CB2) | | | | | |
| Input Leakage Current R/W, RESET, RS0, RS1, CS0, CS1, CS2, CA1, | I _{in} | _ | 10 | 25 | μΑ |
| (V _{In} = 0 to 5 25 V) CB1, Enable | | | 2 0 | 10 | |
| Three-State Input Leakage Current (V _{In} = 0 4 to 2 4 V) PB0-PB7, CB2 | IIZ | | - 400 | | μΑ |
| Input High Current (V _{IH} = 2 4 V) PA0-PA7, CA2 | ИН | - 200 | - 400 | _ _ 10 | μA mA |
| Darlington Drive Current (V _O = 1 5 V) PB0-PB7, CB2 | ЮН | -10 | - 12 | | |
| Input Low Current (V _{IL} = 0 4 V) PA0-PA7, CA2 | 11L | | -13 | -24 | mA |
| Output High Voltage (IL pad = -200 µA) PA0-PA7, PB0-PB7, CA2, CB2 | Voн | VSS+24 | ĺ | | V |
| $(I_{Load} = -200 \mu\text{A})$ PA0-PA7, PB0-PB7, CA2, CB2 $(I_{Load} = -10 \mu\text{A})$ PA0-PA7, CA2 | VOH | V _{CC} -10 | _ | _ | . * |
| Output Low Voltage (I _{Load} = 3.2 mA) | VOL | | | V _{SS} +04 | V |
| Capacitance (V _{In} =0, T _A =25°C, f=1 0 MHz) | C _{in} | | | 10 | pF |
| POWER REQUIREMENTS | | L | L | | L . |
| Internal Power Dissipation (Measured at $T_A = T_1$) | PINT | Γ- | T - | 550 | mW |
| Т | 1 1111 | | L | | L |

BUS TIMING CHARACTERISTICS (See Notes 1 and 2)

| ident. | Characteristic | Cumbal | MC6821 | | MC68A21 | | MC68B21 | | Unit |
|--------|---------------------------------|---------------------------------|--------|-----|---------|-----|---------|-----|------|
| Number | Characteristic | Symbol | Min | Max | Min | Max | Min | Max | Unit |
| 1 | Cycle Time | tcyc | 10 | 10 | 0 67 | 10 | 05 | 10 | μS |
| 2 | Pulse Width, E Low | PWEL | 430 | - | 280 | - | 210 | - | ns |
| 3 | Pulse Width, E High | PWEH | 450 | - | 280 | - | 220 | - | ns |
| 4 | Clock Rise and Fall Time | t _r , t _f | - | 25 | - | 25 | - | 20 | ns |
| 9 | Address Hold Time | tAH | 10 | - | 10 | - | 10 | - | ns |
| 13 | Address Setup Time Before E | †AS | 80 | _ | 60 | - | 40 | _ | ns |
| 14 | Chip Select Setup Time Before E | tcs | 80 | - | 60 | I - | 40 | - | ns |
| 15 | Chip Select Hold Time | t _C H | 10 | - | 10 | - | 10 | - | ns |
| 18 | Read Data Hold Time | tDHR | 20 | 100 | 20 | 100 | 20 | 100 | ns |
| 21 | Write Data Hold Time | tDHW | 10 | - | 10 | - | 10 | - | ms |
| 30 | Output Data Delay Time | †DDR | - | 290 | - | 180 | - | 150 | ns |
| 31 | Input Data Setup Time | tDSW | 165 | - | 80 | - | 60 | - | ns |

FIGURE 1 - BUS TIMING



Notes

- 1 Voltage levels shown are V_L \leq 0 4 V, V_H \geq 2 4 V, unless otherwise specified 2 Measurement points shown are 0 8 V and 2 0 V, unless otherwise specified

PERIPHERAL TIMING CHARACTERISTICS ($V_{CC} = 5.0 \text{ V} \pm 5\%$, $V_{SS} = 0 \text{ V}$, $T_A = T_L$ to T_H unless otherwise specified)

| Characteristic | | MC6821 | | MC68A21 | | MC6 | 8B21 | Unit | Reference |
|--|---------------------------------|--------|------|---------|-------|-----|-------|------|-----------|
| Characteristic | Symbol | Min | Max | Min | Max | Min | Max | Unit | Fig. No. |
| Data Setup Time | tPDS | 200 | - | 135 | _ | 100 | - | ns | 6 |
| Data Hold Time | tPDH | 0 | - | 0 | _ | 0 | _ | ns | 6 |
| Delay Time, Enable Negative Transition to CA2 Negative Transition | t _{CA2} | _ | 10 | _ | 0 670 | | 0 500 | μS | 3, 7, 8 |
| Delay Time, Enable Negative Transition to CA2 Positive Transition | T _{RS1} | - | 10 | _ | 0 670 | | 0 500 | μS | 3, 7 |
| Rise and Fall Times for CA1 and CA2 Input Signals | t _r , t _f | | 10 | _ | 10 | _ | 10 | μS | 8 |
| Delay Time from CA1 Active Transition to CA2 Positive Transition | tRS2 | _ | 20 | - | 1 35 | - | 10 | μS | 3, 8 |
| Delay Time, Enable Negative Transition to Data Valid | tPDW | _ | 10 | - | 0 670 | | 05 | μS | 3, 9, 10 |
| Delay Time, Enable Negative Transition to CMOS Data Valid PA0-PA7, CA2 | tcmos | - | 20 | _ | 1 35 | _ | 10 | μs | 4, 9 |
| Delay Time, Enable Positive Transition to CB2 Negative Transition | tCB2 | _ | 10 | _ | 0.670 | - | 0.5 | μS | 3, 11, 12 |
| Delay Time, Data Valid to CB2 Negative Transition | tDC | 20 | - | 20 | _ | 20 | _ | ns | 3, 10 |
| Delay Time, Enable Positive Transition to CB2 Positive Transition | tRS1 | - | 10 | - | 0.670 | _ | 0.5 | μs | 3, 11 |
| Control Output Pulse Width, CA2/CB2 | PWCT | 500 | - | 375 | - | 250 | _ | ns | 3, 11 |
| Rise and Fall Time for CB1 and CB2 Input Signals | t _r , t _f | _ | 10 | _ | 10 | - | 10 | μ | 12 |
| Delay Time, CB1 Active Transition to CB2 Positive Transition | tRS2 | _ | 2.0 | _ | 1 35 | - | 10 | μS | 3, 12 |
| Interrupt Release Time, IRQA and IRQB | tIR | - | 1 60 | _ | 1 10 | - | 0 85 | μS | 5, 14 |
| Interrupt Response Time | tRS3 | _ | 10 | _ | 10 | _ | 10 | μS | 5, 13 |
| Interrupt Input Pulse Time | PWI | 500 | - | 500 | _ | 500 | | ns | 13 |
| RESET Low Time* | tRL | 10 | | 0 66 | | 05 | | μS | 15 |

^{*}The $\overline{\text{RESET}}$ line must be high a minimum of 1 0 μs before addressing the PIA

FIGURE 2 - BUS TIMING TEST LOADS

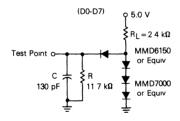


FIGURE 3 — TTL EQUIVALENT TEST LOAD

(PA0-PA7, PB0-PB7, CA2, CB2)

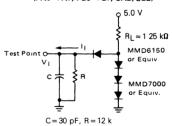


FIGURE 4 — CMOS EQUIVALENT TEST LOAD

(PA0-PA7, CA2)

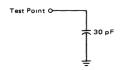


FIGURE 5 — NMOS EQUIVALENT TEST LOAD

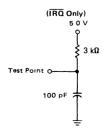


FIGURE 6 - PERIPHERAL DATA SETUP AND HOLD TIMES (Read Mode)

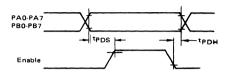


FIGURE 7 - CA2 DELAY TIME (Read Mode; CRA-5 = CRA3 = 1, CRA-4 = 0)

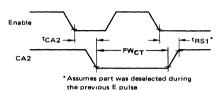


FIGURE 8 - CA2 DELAY TIME (Read Mode: CRA-5=1, CRA-3=CRA-4=0)

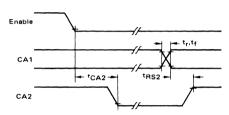


FIGURE 9 - PERIPHERAL CMOS DATA DELAY TIMES (Write Mode; CRA-5 = CRA-3 = 1, CRA-4 = 0)

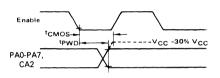


FIGURE 10 - PERIPHERAL DATA AND CB2 DELAY TIMES (Write Mode; CRB-5 = CRB-3 = 1, CRB-4 = 0)

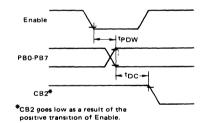
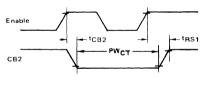


FIGURE 11 - CB2 DELAY TIME (Write Mode; CRB-5 = CRB-3 = 1, CRB-4 = 0)



*Assumes part was deselected during the previous E pulse

FIGURE 12 - CB2 DELAY TIME (Write Mode: CRB-5=1, CRB-3=CRB-4=0)

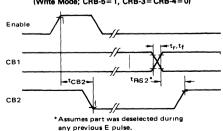
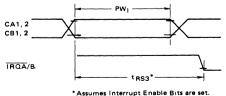


FIGURE 13 - INTERRUPT PULSE WIDTH AND $\overline{\text{IRQ}}$ RESPONSE



Note Timing measurements are referenced to and from a low voltage of 0.8 volts and a high voltage of 2.0 volts, unless otherwise noted.



Note Timing measurements are referenced to and from a low voltage of 0.8 volts and a high voltage of 2.0 volts, unless otherwise noted

FIGURE 16 - EXPANDED BLOCK DIAGRAM IRQA 38 - 40 CA1 Interrupt Status Control A - 39 CA2 Control Register A D0 33 🔫 (CRA) D1 32 🖚 Data Direction Register A D2 31 -Data Bus D3 30 🖚 Buffers (DBB) D4 29 🔫 Output Bus D5 28 🔫 2 PAO D6 27 Output PA1 Register A (ORA) PA2 Peripheral 5 PA3 Interface 6 PA4 7 PA5 Bus **Bus Input** 8 PA6 Register (BIR) Input 9 PA7 V_{CC} = Pin 20 10 PB0 VSS - Pin 1 Output 11 PB1 Register B 12 PB2 CSO 22 Peripheral 13 PB3 Interface CS1 24 14 PB4 CS2 23 Chip 15 PB5 Select RS0 36 16 PB6 and RS1 35 R/W 17 PB7 Control R/W 21 Enable 25 RESET 34 Data Direction Control Register B Register B (DDRB) -- 18 CB1 Interrupt Status Control B IRQB 37 ◀ ► 19 CB2

PIA INTERFACE SIGNALS FOR MPU

The PIA interfaces to the M6800 bus with an 8-bit bidirectional data bus, three chip select lines, two register select lines, two interrupt request lines, a read/write line, an enable line and a reset line. To ensure proper operation with the MC6800, MC6802, or MC6808 microprocessors, VMA should be used as an active part of the address decoding.

Bidirectional Data (D0-D7) — The bidirectional data lines (D0-D7) allow the transfer of data between the MPU and the PIA. The data bus output drivers are three-state devices that remain in the high-impedance (off) state except when the MPU performs a PIA read operation. The read/write line is in the read (high) state when the PIA is selected for a read operation.

Enable (E) — The enable pulse, E, is the only timing signal that is supplied to the PIA. Timing of all other signals is referenced to the leading and trailing edges of the E pulse.

Read/Write (R/W) — This signal is generated by the MPU to control the direction of data transfers on the data bus. A low state on the PIA read/write line enables the input buffers and data is transferred from the MPU to the PIA on the E signal if the device has been selected. A high on the read/write line sets up the PIA for a transfer of data to the bus. The PIA output buffers are enabled when the proper address and the enable pulse E are present.

RESET — The active low RESET line is used to reset all register bits in the PIA to a logical zero (low). This line can be used as a power-on reset and as a master reset during system operation.

Chip Selects (CS0, CS1, and $\overline{\text{CS2}}$) — These three input signals are used to select the PIA. CS0 and CS1 must be high and $\overline{\text{CS2}}$ must be low for selection of the device. Data transfers are then performed under the control of the enable and read/write signals. The chip select lines must be stable

for the duration of the E pulse. The device is deselected when any of the chip selects are in the inactive state.

Register Selects (RS0 and RS1) — The two register select lines are used to select the various registers inside the PIA. These two lines are used in conjunction with internal Control Registers to select a particular register that is to be written or read.

The register and chip select lines should be stable for the duration of the E pulse while in the read or write cycle.

Interrupt Request (IROA and IROB) — The active low Interrupt Request lines (IROA and IROB) act to interrupt the MPU either directly or through interrupt priority circuitry. These lines are "open drain" (no load device on the chip). This permits all interrupt request lines to be tied together in a wire-OR configuration.

Each Interrupt Request line has two internal interrupt flag bits that can cause the Interrupt Request line to go low. Each flag bit is associated with a particular peripheral interrupt line. Also, four interrupt enable bits are provided in the PIA which may be used to inhibit a particular interrupt from a peripheral device.

Servicing an interrupt by the MPU may be accomplished by a software routine that, on a prioritized basis, sequentially reads and tests the two control registers in each PIA for interrupt flag bits that are set.

The interrupt flags are cleared (zeroed) as a result of an MPU Read Peripheral Data Operation of the corresponding data register. After being cleared, the interrupt flag bit cannot be enabled to be set until the PIA is deselected during an E pulse. The E pulse is used to condition the interrupt control lines (CA1, CA2, CB1, CB2). When these lines are used as interrupt inputs, at least one E pulse must occur from the inactive edge to the active edge of the interrupt input signal to condition the edge sense network. If the interrupt flag has been enabled and the edge sense circuit has been properly conditioned, the interrupt flag will be set on the next active transition of the interrupt input pin.

PIA PERIPHERAL INTERFACE LINES

The PIA provides two 8-bit bidirectional data buses and four interrupt/control lines for interfacing to peripheral devices.

Section A Peripheral Data (PA0-PA7) — Each of the peripheral data lines can be programmed to act as an input or output. This is accomplished by setting a "1" in the corresponding Data Direction Register bit for those lines which are to be outputs. A "0" in a bit of the Data Direction Register causes the corresponding peripheral data line to act as an input. During an MPU Read Peripheral Data Operation, the data on peripheral lines programmed to act as inputs appears directly on the corresponding MPU Data Bus lines. In the input mode, the internal pullup resistor on these lines represents a maximum of 1.5 standard TTL loads.

The data in Output Register A will appear on the data lines that are programmed to be outputs. A logical "1" written into the register will cause a "high" on the corresponding data

Inne while a "0" results in a "low." Data in Output Register A may be read by an MPU "Read Peripheral Data A" operation when the corresponding lines are programmed as outputs. This data will be read property if the voltage on the peripheral data lines is greater than 2.0 volts for a logic "1" output and less than 0.8 volt for a logic "0" output. Loading the output lines such that the voltage on these lines does not reach full voltage causes the data transferred into the MPU on a Read operation to differ from that contained in the respective bit of Output Register A.

Section B Peripheral Data (PB0-PB7) — The peripheral data lines in the B Section of the PIA can be programmed to act as either inputs or outputs in a similar manner to PA0-PA7. They have three-state capability, allowing them to enter a high-impedance state when the peripheral data line is used as an input. In addition, data on the peripheral data lines

PB0-PB7 will be read properly from those lines programmed as outputs even if the voltages are below 2.0 volts for a "high" or above 0.8 V for a "low". As outputs, these lines are compatible with standard TTL and may also be used as a source of up to 1 milliampere at 1.5 volts to directly drive the base of a transistor switch:

Interrupt Input (CA1 and CB1) — Peripheral input lines CA1 and CB1 are input only lines that set the interrupt flags of the control registers. The active transition for these signals is also programmed by the two control registers.

Peripheral Control (CA2) — The peripheral control line CA2 can be programmed to act as an interrupt input or as a

peripheral control output. As an output, this line is compatible with standard TTL; as an input the internal pullup resistor on this line represents 1.5 standard TTL loads. The function of this signal line is programmed with Control Register A.

Peripheral Control (CB2) — Peripheral Control line CB2 may also be programmed to act as an interrupt input or peripheral control output. As an input, this line has high input impedance and is compatible with standard TTL. As an output it is compatible with standard TTL and may also be used as a source of up to 1 milliampere at 1.5 volts to directly drive the base of a transistor switch. This line is programmed by Control Register B.

INTERNAL CONTROLS

INITIALIZATION

A RESET has the effect of zeroing all PIA registers. This will set PAO-PA7, PBO-PB7, CA2 and CB2 as inputs, and all interrupts disabled. The PIA must be configured during the restart program which follows the reset.

There are six locations within the PIA accessible to the MPU data bus: two Peripheral Registers, two Data Direction Registers, and two Control Registers. Selection of these locations is controlled by the RSO and RS1 inputs together with bit 2 in the Control Register, as shown in Table 1.

Details of possible configurations of the Data Direction and Control Register are as follows:

TABLE 1 - INTERNAL ADDRESSING

| | | Control Register Bit | | |
|-----|-----|-------------------------|-------|---------------------------|
| RS1 | RS0 | CRA-2 | CRB-2 | Location Selected |
| 0 | 0 | 1 | × | Peripheral Register A |
| 0 | 0 | 0 | Х | Data Direction Register A |
| 0 | 1 | Х | Х | Control Register A |
| 1 | 0 | × | 1 | Peripheral Register B |
| 1 | 0 | × | 0 | Data Direction Register B |
| 1 | 1 | × | × | Control Register B |

X = Don't Care

PORT A-B HARDWARE CHARACTERISTICS

As shown in Figure 17, the MC6821 has a pair of I/O ports whose characteristics differ greatly. The A side is designed to drive CMOS logic to normal 30% to 70% levels, and incorporates an internal pullup device that remains connected even in the input mode. Because of this, the A side requires more drive current in the input mode than Port B. In context, the B side uses a normal three-state NMOS buffer which cannot pullup to CMOS levels without external resistors. The B side can drive extra loads such as Darlingtons without problem. When the PIA comes out of reset, the A port represents inputs with pullup resistors, whereas the B side (input mode also) will float high or low, depending upon the load connected to it.

Notice the differences between a Port A and Port B read operation when in the output mode. When reading Port A, the actual pin is read, whereas the B side read comes from an output latch, ahead of the actual pin.

CONTROL REGISTERS (CRA and CRB)

The two Control Registers (CRA and CRB) allow the MPU to control the operation of the four peripheral control lines CA1, CA2, CB1, and CB2. In addition they allow the MPU to enable the interrupt lines and monitor the status of the interrupt flags. Bits 0 through 5 of the two registers may be written or read by the MPU when the proper chip select and register select signals are applied. Bits 6 and 7 of the two registers are read only and are modified by external interrupts occurring on control lines CA1, CA2, CB1, or CB2. The format of the control words is shown in Figure 18.

DATA DIRECTION ACCESS CONTROL BIT (CRA-2 and CRB-2)

Bit 2, in each Control Register (CRA and CRB), determines selection of either a Peripheral Output Register or the corresponding Data Direction E Register when the proper register select signals are applied to RSO and RS1. A "1" in bit 2 allows access of the Peripheral Interface Register, while a "0" causes the Data Direction Register to be addressed.

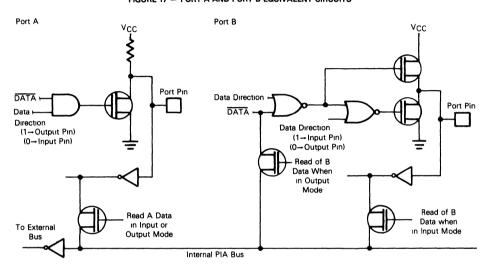
Interrupt Flags (CRA-6, CRA-7, CRB-6, and CRB-7) — The four interrupt flag bits are set by active transitions of signals on the four Interrupt and Peripheral Control lines when those lines are programmed to be inputs. These bits cannot be set directly from the MPU Data Bus and are reset indirectly by a Read Peripheral Data Operation on the appropriate section.

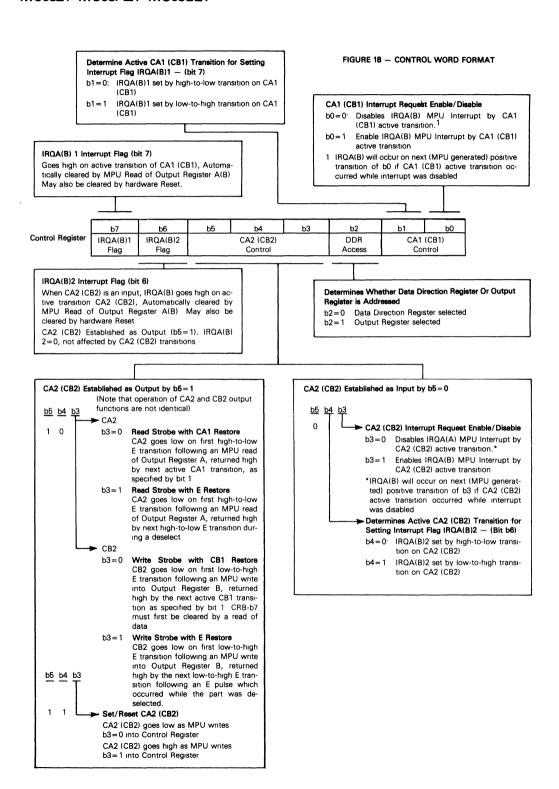
Control of CA2 and CB2 Peripheral Control Lines (CRA-3, CRA-4, CRA-5, CRB-3, CRB-4, and CRB-5) — Bits 3, 4, and 5 of the two control registers are used to control the CA2 and CB2 Peripheral Control lines. These bits determine if the control lines will be an interrupt input or an output control signal. If bit CRA-5 (CRB-5) is low, CA2 (CB2) is an interrupt input line similar to CA1 (CB1). When CRA-5 (CRB-5) is high, CA2 (CB2) becomes an output signal that may be used to control peripheral data transfers. When in the output mode, CA2 and CB2 have slightly different loading characteristics.

Control of CA1 and CB1 Interrupt Input Lines (CRA-0, CRB-1, CRA-1, and CRB-1) — The two lowest-order bits of the control registers are used to control the interrupt input lines CA1 and CB1. Bits CRA-0 and CRB-0 are used to

enable the MPU interrupt signals \overline{IRQA} and \overline{IRQB} , respectively. Bits CRA-1 and CRB-1 determine the active transition of the interrupt input signals CA1 and CB1.

FIGURE 17 - PORT A AND PORT B EQUIVALENT CIRCUITS







MC6822

Product Preview

INDUSTRIAL INTERFACE ADAPTER

The MCM6822 Industrial Interface Adapter (IA) provides the universal means of interfacing industrial peripheral equipment with the MC6800 Microprocessor Unit (MPU). This device is capable of interfacing the MPU with industrial peripherals through two 8-bit bidirectional peripheral parts and four control lines. No external logic is required for interfacing with most peripheral devices. Due to the open-drain design, Peripheral Ports A and B, as well as the peripheral control lines (CA1, CA2, CB1, CB2) can be pulled-up externally to 18 0 V maximum. The recommended operating voltage range for these ports is between 0 and 15 volts. Thus, the IIA can directly interface with 15 V CMOS (no level shifters are required). The IIA is also ideal for industrial applications when increased noise margins are required.

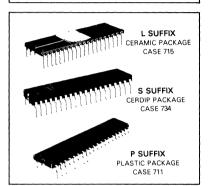
The functional configuration of the IIA is programmed by the MPU during system initialization. Each of the peripheral data lines can be programmed to act as an input or output, and each of the four control/interrupt lines may be programmed for one of several control modes. This allows a high degree of flexibility in the overall operation of the interface.

- 8-Bit Bidirectional Data Bus for Communication with the MPU
- Two Bidirectional 8-Bit Ports for Interface with Peripherals
- Two Programmable Control Registers
- Two Programmable Data Direction Registers
- Four Individually-Controlled Interrupt Lines, Two Usable as Peripheral Control Outputs
- Handshake Control Logic for Input and Output Peripheral Operation
- Open Drain Peripheral Lines Capable of Interfacing with Industrial Equipment
- Program Controlled Interrupt and Interrupt Disable Capability
- CMOS Drive Capability on All Peripheral Lines
- Pin Compatible with MC6821 PIA
- TTL-Compatible Data Bus
- Fully Static Operation

MOS

(N-CHANNEL, SILICON-GATE DEPLETION LOAD)

INDUSTRIAL INTERFACE ADAPTER



| PIN ASSI | GNMENT |
|-----------------------------|-----------------|
| Vsst 1 • | 40 CA1 |
| PA0 [2 | 39 CA2 |
| PA1 []3 | 38 IRQA |
| PA2 C 4 | 37 IRQB |
| PA3 [5 | 36 1 RS0 |
| PA4 □ 6 | 35 1 RS1 |
| PA5 [7 | 34 ☐ RESET |
| PA6 [8 | 33 1 D0 |
| PA7 [9 | 32 D D1 |
| РВ0 [10 | 31 D D2 |
| PB1 [11 | 30 D D3 |
| PB2 [12 | 29 D D4 |
| PB3 [13 | 28 D D5 |
| PB4 [14 | 27 1 D6 |
| PB5 ₵ 15 | 26 1 D7 |
| PB6 C 16 | 25 T E |
| PB7 [17 | 24 1 CS1 |
| CB1 [18 | 23 TCS2 |
| СВ2 [19 | 22 1 CS0 |
| V _{CC} L 20 | 21 1 R/W |

IIA INTERFACE SIGNALS FOR MPU

The IIA interfaces with the MC6800 MPU via an 8-bit bidirectional data bus, three chip select lines, two register select lines, two interrupt request lines, read/write line, enable line, and reset line. These signals, in conjunction with the MC6800 VMA output, permit the MPU to have complete control over the IIA. VMA should be utilized in conjunction with an MPU address line into a chip select of the IIA

IIA BIDIRECTIONAL DATA (D0-D7)

The bidirectional data lines (D0-D7) allow the transfer of data between the MPU and the IIA. The data bus output drivers are three-state devices that remain in the high-impedance (off) state except when the MPU performs an IIA read operation. The Read/Write line is in the Read (high) state when the IIA is selected for a Read operation.

IIA ENABLE (E)

The enable pulse, E, is the only timing signal that is supplied to the IIA. Timing of all other signals is referenced to the leading and trailing edges of the E pulse. This signal will normally be a derivative of the MC6800 42 Clock.

IIA READ/WRITE (R/W)

This signal is generated by the MPU to control the direction of data transfers on the Data Bus. A low state on the IIA Read/Write line enables the input buffers and data is transferred from the MPU to the IIA by the E signal if the device has been selected. A high on the Read/Write line sets up the IIA for a transfer of data to the bus. The IIA output buffers are enabled when the proper address and the enable pulse E are present.

RESET

The active low RESET line is used to reset all register bits in the IIA to a logical zero (low). This line can be used as a power-on reset and as a master reset during system operation.

IIA CHIP SELECT (CS0-CS1 AND CS2)

These three input signals are used to select the IIA CS0 and CS1 must be high and CS2 must be low for selection of the device Data transfers are then performed under the con-

trol of the Enable and Read/Write signals. The chip select lines must be stable for the duration of the E pulse. The device is deselected when any of the chip selects are in the inactive state.

IIA REGISTER SELECT (RS0 AND RS1)

The two register select lines are used to select the various registers inside the IIA. These two lines are used in conjunction with internal Control Registers to select a particular register that is to be written or read.

The register and chip select lines should be stable for the duration of the E pulse while in the read or write cycle

INTERRUPT REQUEST (IRQA AND IRQB)

The active low Interrupt Request lines (IRQA and IRQB) act to interrupt the MPU either directly or through interrupt priority circuitry. These lines are "open drain" (no load device on the chip). This permits all interrupt request lines to be tied together in a wire-OR configuration.

Each Interrupt Request line has two internal interrupt flag bits that can cause the Interrupt Request line to go low. Each flag bit is associated with a particular peripheral interrupt line. Also, four interrupt enable bits are provided in the IIA which may be used to inhibit a particular interrupt from a peripheral device.

Servicing an interrupt by the MPU may be accomplished by a software routine that, on as prioritized basis, sequentially reads and tests the two control registers in each IIA for interrupt flag bits that are set.

The interrupt flags are cleared (zeroed) as a result of an MPU Read Peripheral Data Operation of the corresponding data register. After being cleared, the interrupt flag bit cannot be enabled to be set until the IIA is deselected during an E pulse. The E pulse is used to condition the interrupt control lines (CA1, CA2, CB1, CB2). When these lines are used as interrupt inputs, at least one E pulse must occur from the inactive edge to the active edge of the interrupt input signal to condition the edge sense network. If the interrupt flag has been enabled and the edge sense circuit has been properly conditioned, the interrupt flag will be set on the next active transition of the interrupt input pin

IRQB 37 →

EXPANDED BLOCK DIAGRAM IRQA 38 40 CA1 Interrupt Status Control A - 39 CA2 Control Register A (CRA) D0 33 🔫 D1 32 Data Direction Register A (DDRA) D2 31 Data Bus D3 30 Buffers D4 29 (DBB) Output Bus D5 28 2 PA0 D6 27 Output 3 PA1 D7 26 🕳 Register A (ORA) 4 PA2 Industrial 5 PA3 Interface 6 PA4 Α 7 PA5 Input Bus Bus Input 8 PA6 Register (BIR) V_{CC} = P_In 20 V_{SS} = P_In 1 10 PBO Output 11 PB1 Register B (ORB) 12 PB2 Industrial CSO 22 13 PB3 Interface CS1 24 14 PB4 В CS2 23 Chip 15 PB5 Select RS0 36 16 PB6 and R W RS1 35 ► 17 PB7 Control R/W 21 Enable 25 RESET 34 Data Direction Control Register B (DDRB) Register B (CRB) - 18 CB1

Interrupt Status Control B

► 19 CB2



PRIORITY INTERRUPT CONTROLLER

The MC6828/8507 Priority Interrupt Controller (PIC) is used to add prioritized responses to inputs to microprocessor systems. The performance has been optimized for the M6800X system, but will serve to eliminate input polling routines from any processor system

The MC6828/8507 (PIC) modifies the vector ROM addresses that the microprocessor uses to jump to an interrupt routine. The MC6828 provides the user with an additional eight latched interrupt inputs, and it can be cascaded to provide more interrupts.

An interrupt mask prevents any latched interrupt input of lower priority than the mask level from generating an IRO output.

The (PIC) allows for any added decode time by generating a Stretch signal which can be used to slow the processor clock while fetching interrupt routine starting addresses. The Stretch signal allows the interrupt structure to be designed without concern for faster operation due to improvements in processor speeds

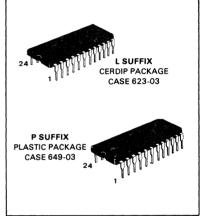
BLOCK DIAGRAM Latched Inputs IN7 11 0 1-of-8 IN6 10 0-Priority Vector IN5 9 0 Encoder 8-Bit _ook-Up N4 8 o-Request Mask / Table ĪN3 7 0-Register Inputs IN2 6 0 Below Mask 5 o IN1 INO 4 Level Are Inhibited -0 23 INT = Not Selected Vector Mask Location Load E 18 0-R/W 17 0-Select Register Decode CS0 3 o and Select Vector Function CS1 0 22 74 or Address Control Quad 21 Z3 1-of-2 Address A4 13 0 Select Bus A3 14 0 A2 15 0 o 2 Stretch A1 16 0 V_{CC} = Pin 24 Gnd = Pin 12

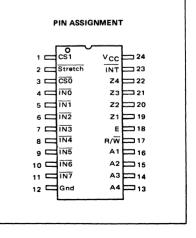
MC6828 MC8507

Note: The dual numbering system emphasis that this device is a bipolar LSI service and directly compatible with the M6800X Microprocessor Family The Priority Interrupt Controller may be ordered by using either part number

MEGALOGIC

PRIORITY INTERRUPT CONTROLLER





MAXIMUM RATINGS

| Rating | Symbol | Value | Unit |
|----------------|-----------------|---------------|------|
| Supply Voltage | Vcc | -0 5 to + 7 0 | Vdc |
| Input Voltage | V _{in} | -1 0 to +5 5 | Vdc |
| Output Voltage | Voн | -0 4 to +7 0 | Vdc |

THERMAL CHARACTERISTICS

| Characteristic | Symbol | Max | Unit |
|-----------------------------------|-----------------|-----------|------|
| Thermal Resistance Cerdip Plastic | $R_{\theta JA}$ | 65 120 | °C/W |

POWER CONSIDERATIONS

The average chip-junction temperature, T_J, in °C can be obtained from

$$T_{J} = T_{A} + (P_{D} \cdot \theta_{JA}) \tag{1}$$

Where

T_A ≡ Ambient Temperature, °C

 $\theta_{JA} \equiv Package Thermal Resistance, Junction-to-Ambient, °C/W$

P_D ≡ P_{INT} + P_PORT

PINT ≡ I_{CC} × V_{CC}, Watts — Chip Internal Power
PPORT ≡ Port Power Dissipation, Watts — User Determined

For most applications PPORT ≪ PINT and can be neglected. PPORT may become significant if the device is configured to drive Darlington bases or sink LED loads.

An approximate relationship between PD and TJ (if PPORT is neglected) is:

$$P_D = K \div (T_J + 273^{\circ}C)$$
 (2)

Solving equations 1 and 2 for K gives:

 $K = P_D [T_A + 273^{\circ}C + (P_D \cdot \theta_{JA})]$

Where K is a constant pertaining to the particular part. K can be determined from equation (3) by measuring PD (at equilibrium) for a known TA Using this value of K the values of PD and TJ can be obtained by solving equations (1) and (2) iteratively for any value of Ta

ELECTRICAL CHARACTERISTICS (V_{CC} = 5 0 Vdc ±5%, T_A = 0 to 75°C unless otherwise noted)

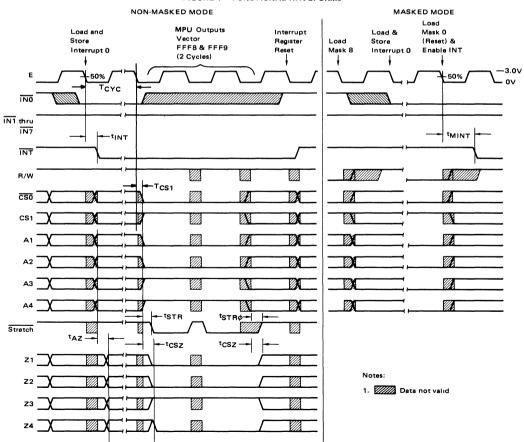
| Characteristi | С | Symbol | Min | Max | Unit |
|--|--|--------|------------------|------------------------------|------|
| Input Forward Current (V _{IL} = 0, V _{CC} = 5 25 Vdc) | CS1, E CS0, R/W A1 thru A4 IN0 thru IN7 | IIL | _ _ _ | -75 -150 -225 -1300 | μAdc |
| Input Leakage Current (V _{IH} = 2 4 Vdc, V _{CC} = 5 25 Vdc) | CS1 CS0 A1 thru A4 1N0 thru IN7 | ΊΗ | _ _ _ _ | 120 240 360 -560 | μAdc |
| DC Logic "0" Output Voltage (I _{OL} = 1 6 mAdc, V _{IL} T = 0 8 Vdc, V _{IHT} = 2 0 Vdc, V _{CC} = 4 75 Vdc) (I _{OL} = 3 2 mAdc, V _{CC} = 4 75 Vdc) | Z1 thru Z4, Stretch | VOL | _ | 0 5 0.5 | Vdc |
| DC Logic ''1'' Output Voltage (I _{OH} = -0 3 mAdc, V _{ILT} = 0 8 Vdc, V _{IHT} = 2 0 Vdc, V _{CC} = 4 75 Vdc) | Z1 thru Z4, Stretch | Voн | 2 4 | _ | Vdc |
| Output Leakage Current (V _{CC} = V _{CEX} = 5 25 Vdc) | ĪNT | ICEX | _ | 200 | μAdc |
| Power Supply Drain Current (V _{CC} = 5 0 Vdc, All Inputs Open) | | ¹cc | | 125 | mAdc |

SWITCHING TIMES (VCC = 5 0 Vdc, TA = 25°C)

| Characteristic | Symbol | Min | Max | Unit |
|--|-----------------------|-----|----------------|------|
| A _I to Z _I Delay Time (Not Selected) | t _{AZ} | _ | 75 | ns |
| A _i to Z _i Delay Time (Selected) | †AZ | _ | 60 | ns |
| Select* to Z ₁ Delay Time (Ā1 · Ā2 · A3 · A4 · CS0 · CS1 to Z ₁) | tcsz | | 125 | ns |
| Enable Pulse Width | TCYC | 100 | _ | ns |
| Enable Low to CS1 | T _{CS1} | 125 | | ns |
| Deselect to Stretch High | ^t STRφ | _ | 125 | ns |
| Select* to Stretch Delay Time (A1 · A2 · A3 · A4 · CSO · CS1 to Stretch) | ^t STR | _ | 140 | ns |
| Enable to INT Delay Time, Non-Masked Mode | ^t INT | _ | 240 | ns |
| Enable to INT Delay Time, Masked Mode | tMINT(IN1) tMINT(INJ) | - | 360** 200** | ns |

^{*}Select = (A1 A2 A3 A4 CSO CS1 R/W) which corresponds to FFF8 or FFF9 interrupt response in the M6800 system

FIGURE 1 - FUNCTIONAL WAVEFORMS



^{**}Value depends on mask level and stored priority input. Maximum value occurs with mask level 7 and stored interrupt INO. Minimum value occurs with mask level J and stored interrupt IN(J)

OPERATING CHARACTERISTICS

The primary purpose of the Priority Interrupt Controller (PIC) is to generate a modified address to ROM in response to prioritized inputs. With the PIC, each interrupting device is assigned a unique ROM location which contains the starting address of the appropriate service routine. After the MPU detects and responds to an interrupt, the PIC directs the MPU to the proper memory location.

The basic functions of the PIC are shown in the block diagram. The 8-bit request register is an edge clocked D-typeregister with internal $6\,\mathrm{k}\Omega$ pullup resistors on the interrupt inputs (INO thru IN7). Note the inputs are active low. The interrupt register is loaded on the falling edge of the enable when the PIC is not selected.

The 1-of-8 priority encoder enables a vector corresponding to the stored interrupt with the highest priority and places it on the vector input port of a data selector. In addition an interrupt request signal $\overline{\text{INT}}$ is generated to signal the MPU that an interrupt has been detected. The mask location register overrides and inhibits all interrupts with priority below the mask level. The mask can be thought of as a movable partition allowing responses to inputs equal to or greater than the mask value. For example, if the stored mask level was 4, inputs $\overline{\text{INO}}$, $\overline{\text{IN1}}$, $\overline{\text{IN2}}$, and $\overline{\text{IN3}}$ would not generate an interrupt to the MPU system. The input request register is not affected by the mask, and if the mask is cleared (by loading it with zeros), any previously stored inputs will generate an IRQ signal

FIGURE 2 — MC6828 TRUTH TABLE FOR M6800 MICROPROCESSOR SYSTEMS

| Active | | Output When Selected | | | | Equivalent to Bits 1-4 of B0, B1 , B15 | Address ROM Bytes |
|---------|------|----------------------|----|----|----|--|---------------------|
| Inpo | ut | Z4 | Z3 | Z2 | Z1 | Hex Address | Contain Address of: |
| Highest | ĪN7 | 1 | 0 | 1 | 1 | F F F 6 or 7 | Priority 7 Routine |
| | IN6 | 1 | 0 | 1 | 0 | FFF4or5 | Priority 6 Routine |
| | IN5 | 1 | 0 | 0 | 1 | FFF2or3 | Priority 5 Routine |
| | IN4 | 1 | 0 | 0 | 0 | FFF0 or 1 | Priority 4 Routine |
| | ĪN3 | 0 | 1 | 1 | 1 | FFEEorF | Priority 3 Routine |
| | IN2 | 0 | 1 | 1 | 0 | F F E C or D | Priority 2 Routine |
| | ĪN1 | 0 | 1 | 0 | 1 | F F E A or B | Priority 1 Routine |
| Lowest | ĪNO | 0 | 1 | 0 | 0 | FFE8or9 | Priority 0 Routine |
| | None | 1 | 1 | 0 | 0 | FFF8or9 | Default Routine* |

^{*}Default routine is the response to interrupt requests not generated by a prioritized input. The default routine may contain polling routines or may be an address in a loop for an interrupt driven system.

FIGURE 3 - MC6828 TRUTH TABLE FOR M6809 MICROPROCESSOR SYSTEMS

| | | • | • | t Whei | n | | | | |
|---------|--------------|----|----|--------|------------|---------------------------|--|--|--|
| | ctive put | Z4 | Z3 | Z2 | Z 1 | Equivalent Hex Address | Address ROM Bytes Contain Address of: | | |
| Highest | IN7 | 1 | 0 | 1 | 1 | FFD6-FFD7 | Priority 7 Routine | | |
| • | IN6 | 1 | 0 | 1 | 0 | FFD4—FFD5 | Priority 6 Routine | | |
| | IN5 | 1 | 0 | 0 | 1 | FFD2—FFD3 | Priority 5 Routine | | |
| | IN4 | 1 | 0 | 0 | 0 | FFDO-FFD1 | Priority 4 Routine | | |
| | IN3 | 0 | 1 | 1 | 1 | FFCE-FFCF | Priority 3 Routine | | |
| | IN2 | 0 | 1 | 1 | 0 | FFCC-FFCD | Priority 2 Routine | | |
| | IN1 | 0 | 1 | 0 | 1 | FFCA — FFCB | Priority 1 Routine | | |
| | INO | 0 | 1 | 0 | 0 | FFC8-FFC9 | Priority O Routine | | |
| Lowest | None | 1 | 1 | 0 | 0 | FF-F 8 — FFF9 | Default Routine (IRQ) | | |

Chip Select and Stretch

The chip select and decode circuitry controls all internal functions of the PIC. The selected mode is defined as the logical AND function A1 · A2 · A3 · A4 · CS0 · CS1 · R/W. When the device is not in the selected mode the request register clock is enabled and the address inputs A₁ passes directly through the data selector to the Z₁ outputs. When the MPU responds to the interrupt request and the PIC decodes the select address, the request register is inhibited and the data selector places the vector on the Z outputs. The address delay added to the MPU system is shown in Figure 4. This delay may be critical in some systems. A stretch signal, which indicates the selected mode, is provided for use with special MPU clock drivers to stretch the clock cycle when accessing slow ROM. This stretch signal is applicable only to those microprocessors which incorporate external clock generators, i.e., 6800, 6809E. The user cannot directly connect stretch to MRDY on the MC6809 or MC6802, as stretching the clock circuit with a signal which is derived from the clock will latch up the MPU An alternative to this problem is to use a one-shot which would provide the required amount of access time Figure 8 illustrates a typical such circuit. The CSO output has one less gating level than the remainder of the select decode logic. This allows an external NAND gate to be used for the full address decode without any increase in delay times

Programming the PIC

Changing the priority level, or mask, in the PIC is done by writing to the device. Unlike normal programming of a peripheral where a specific data pattern is written into selected register, the PIC is programmed by accessing a location determined by A1 through A4 while R/\overline{W} is low.

The decode logic also controls the loading of the mask location register. This register will be loaded on the falling edge of the enable pulse when enabled by the logical AND function $\overline{\text{CSO}} \cdot \text{CSI} \cdot \overline{\text{R/W}}$ (Note 1). This means that in the load mask mode the data on the data bus is a don't care. However, in this mode the ROM will also be accessed and both the ROM and MPU will be driving the data bus. Therefore the read/write line should be used as an active high chip select or enable signal for ROM decoding.

Figure 5 shows the typical operation flow diagram for the PIC in an M6800 system. The functional timing for this flow is as shown in the first part of the waveforms in Figure 1. The second half of Figure 1 shows the operation of the mask. Interrupts will be stored even if they are masked. When the mask is released the $\overline{\text{INT}}$ signal will then be generated.

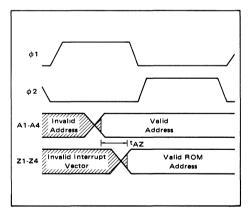
The influence of the mask register on the priority encoder is shown in the truth table of Figure 6. The actual use of the mask register will vary with the system needs and the imaginative software programmer.

Special Cases

As originally conceived, the PIC was only meant to be used with the MC6800 MPU. With the advent of higher performance/function microprocessors such as the MC6809/MC6802/MC6808, prioritized interrupts are still required. The interrupt vector map for the M6800 is located from FFF8 to FFFF With the MC6809, this vector map extends downward to FFF0. As can be seen in Figure 2, the normal configuration of the PIC places priority interrupt vectors from FFE8 to FFF7 which conflict with the existing MC6809 interrupt vectors. Figure 1 shows appropriate circuitry required to interface with the MC6809. Figure 3 gives the "modified priority vectors" associated with this hardware modification.

Note 1 Since during normal operation of the MPU the address lines and the R/W line can be in an indeterminate state, VMA should be logically ANDed with one of the chip select inputs of the PIC to prevent erroneous writes into the mask register (non-6800 systems)

FIGURE 4 — HIGH ROM ADDRESS DELAY ADDED TO M6800X SYSTEMS



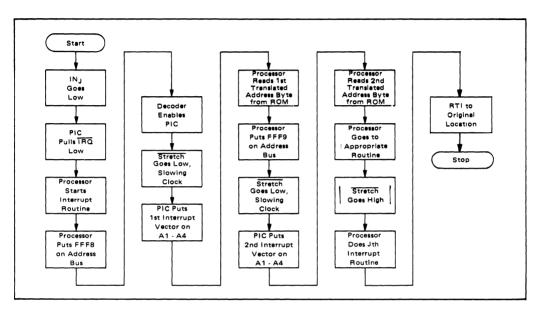


FIGURE 5 — BASIC FUNCTIONAL FLOW CHART

FIGURE 6 - MASK OPERATION

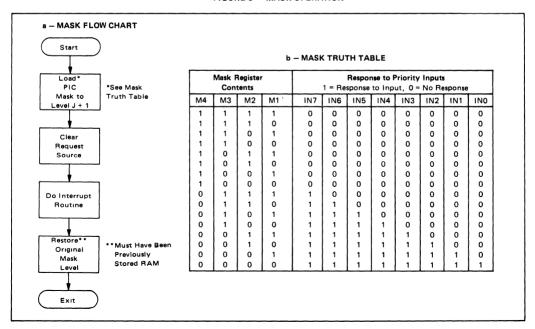


FIGURE 7 — TYPICAL SYSTEM CONFIGURATION

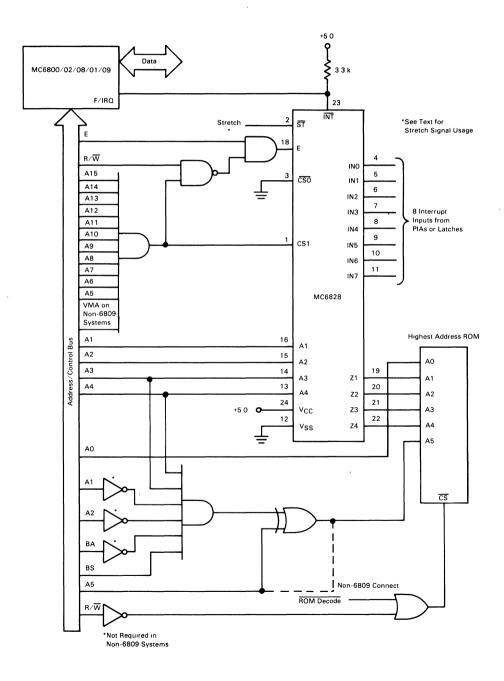
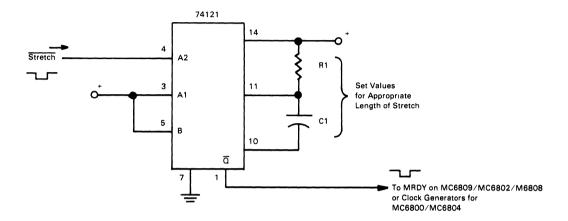
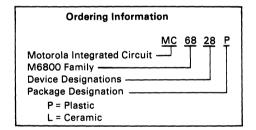


FIGURE 8 — ACCESS TIME EXTENSION USING STRETCH AND MRDY







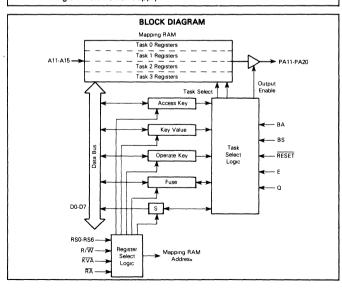
MC6829 (1.0 MHz) MC68A29 (1.5 MHz) MC68B29

Advance Information

MEMORY MANAGEMENT UNIT

The principle function of the MC6829 Memory Management Unit (MMU) is to expand the address space of the MC6809 from 64K bytes to a maximum of 2 Megabytes. Each MMU is capable of handling four different concurrent tasks including DMA. The MMU can also protect the address space of one task from modification by another task. Memory address space expansion is accomplished by applying the upper five address lines of the processor (A11-A15) along with the contents of a 5-bit task register to an internal high-speed mapping RAM. The MMU output consists of ten physical address lines (PA11-PA20) which, when combined with the eleven lower address lines of the processor (A0-A10, forms a physical address space of 2 Megabytes. Each task is assigned memory in increments of 2K bytes up to a total of 64K bytes. In this manner, the address spaces of different tasks can be kept separate from one another. The resulting simplification of the address space programing model will increase the software reliability of a complex multiprocess system.

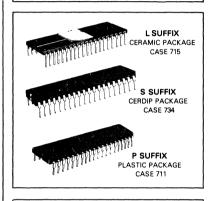
- Expands Memory Address Space from 64K to 2 Megabytes
- Each MMU is Capable of Handling Four Separate Tasks
- Up to Eight MMUs can be Used in a System
- Provides Task Isolation and Write Protection
- Provides Efficient Memory Allocation; 1024 Pages of 2K Bytes Each
- Designed for Efficient Use with DMA
- Fast, Automatic On-Chip Task Switching
- Allows Inter-Process Communication Through Shared Resources
- Simplifies Programming Model of Address Space
- Increases System Software Reliability
- MC6809/MC6800 Bus Compatible
- Single 5-Volt Power Supply



HMOS

(HIGH DENSITY N-CHANNEL, SILICON-GATE)

MEMORY MANAGEMENT UNIT (MMU)



| PIN ASSIGNMENT | | | | | | | |
|--------------------------|----------|----------------------|--|--|--|--|--|
| v _{ss} c | | 40 PA11 | | | | | |
| A15 🕻 | 2 | 39 PA12 | | | | | |
| A14 🛭 | 3 | 38 1 PA13 | | | | | |
| A13 [| 4 | 37 PA14 | | | | | |
| A12 🕻 | 5 | 36 PA15 | | | | | |
| A11 [| 6 | 35 PA16 | | | | | |
| RA C | 7 | 34 1 PA17 | | | | | |
| RS6 [| 8 | 33 1 PA18 | | | | | |
| RS5 [| 9 | 32 1 PA19 | | | | | |
| RS4 [| 10 | 31 PA20 | | | | | |
| RS3 [| 11 | 30 D7 | | | | | |
| RS2 [| 12 | 29 1 D6 | | | | | |
| RS1 [| 13 | 28 1 D5 | | | | | |
| RS0 [| 14 | 27 1 D4 | | | | | |
| KVA | 15 | 26 D3 | | | | | |
| a t | 16 | 25 D D2 | | | | | |
| E₫ | 17 | 24 D1 | | | | | |
| ВА [| 18 | 23 D0 | | | | | |
| вs г | 19 | 22 D V _{CC} | | | | | |
| RESET | 20 | 21 □ R/W | | | | | |
| , | <u> </u> | | | | | | |

MAXIMUM RATINGS

| Characteristics | Symbol | Value | Unit |
|--|------------------|--|------|
| Supply Voltage | Vcc | -0.3 to +7.0 | ٧ |
| Input Voltage | V _{in} | -0.3 to $+7.0$ | ٧ |
| Operating Temperature Range MC6829, MC68A29, MC68B29 MC6829C, MC68A29C, MC68B29C | TA | T _L to T _H 0 to 70 - 40 to +85 | °C |
| Storage Temperature Range | T _{sta} | -55 to +150 | °C |

This device contains circuitry to protect the inputs against damage due to high static voltages or electric fields, however, it is advised that normal precautions be taken to avoid application of any voltage higher than maximum rated voltages to this high-impedance circuit. Reliability of operation is enhanced if unused inputs are tied to an appropriate logic voltage level (e.g., either VSS or VCC)

THERMAL CHARACTERISTICS

| | Symbol | Value | Rating | |
|--------------------|----------|-------|--------|--|
| Thermal Resistance | | | | |
| Plastic | a | 100 | °C/W | |
| Cerdip | θJA | 60 | -C/ VV | |
| Ceramic | | 50 | l | |

POWER CONSIDERATIONS

The average chip-junction temperature, T.j., in °C can be obtained from:

$$T_{J} = T_{A} + (P_{D} \bullet \theta_{JA})$$
Where:

TA = Ambient Temperature, °C

θ₁Δ = Package Thermal Resistance, Junction-to-Ambient, °C/W

PD = PINT + PPORT

PINT=ICC × VCC, Watts - Chip Internal Power

PPORT ■ Port Power Dissipation, Watts — User Determined

For most applications PPORT ◀PINT and can be neglected PPORT may become significant if the device is configured to drive Darlington bases or sink LED loads

An approximate relationship between PD and TJ (if PPORT is neglected) is:

$$P_D = K + (T_{.1} + 273 \,^{\circ}C)$$
 (2)

Solving equations 1 and 2 for K gives

$$K = PD \bullet (TA + 273 \circ C) + \theta JA \bullet PD^2$$
(3)

Where K is a constant pertaining to the particular part. K can be determined from equation 3 by measuring P_D (at equilibrium) for a known T_A . Using this value of K the values of P_D and T_J can be obtained by solving equations (1) and (2) iteratively for any value of T_A .

DC ELECTRICAL CHARACTERISTICS (V_{CC}=5 0 Vdc ±5%, V_{SS}=0, T_A=T_L to T_H unless otherwise noted)

| Characteristic | Symbol | Min | Тур | Max | Unit | |
|--|-----------------------|------------------|--|--------|--|----|
| Input High Voltage | All Inputs | VIH | Vss+20 | - | Vcc | ٧ |
| Input Low Voltage | All Inputs | VIL | VSS-03 | - | V _{SS} +08 | ٧ |
| Input Leakage Current (V _{IN} = 0 to 5 25 V) | V _{CC} = Max | l _{in} | - | 10 | 25 | μА |
| Three-State (Off State) Input Current (V _{In} = 0 4 to 2 4 V) | D0-D7 | ١ız | _ | 20 | 10 | μΑ |
| Output High Voltage $(I_{Oad} = -145 \mu A)$ $V_{CC} = min$ | D0-D7 PA11-PA20 | Vон | V _{SS} +24 V _{SS} +24 | - - | _ _ | ٧ |
| Output Low Voltage (I _{load} = 2 0 mA) V _{CC} = max | D0-D7 PA11-PA20 | VOL | - | - - | V _{SS} +05 V _{SS} +05 | ٧ |
| Internal Power Dissipation (Measured at TA = TL) | | PINT | - | - | 800 | mW |
| Input Capacitance (V _{ID} = 0, T _A = 25°C, f = 1.5 MHz) | All inputs | C _{in} | - | 10 0 | 12.0 | pF |
| Output Capacitance (V _{In} = 0, T _A = 25°C, f = 1 5 MHz) | All Outputs | C _{out} | | | 12 0 | pF |

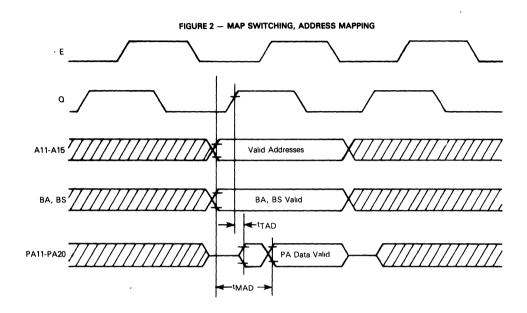
BUS TIMING CHARACTERISTICS (See Notes 1 and 2)

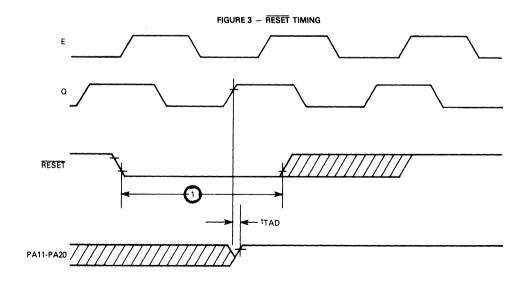
| ldent. | Characteristic | Cumbal | MC6829 | | MC68A29 | | MC68B29 | | |
|------------------------|---------------------------------|---------------------------------|--------|------|---------|------|---------|------|------|
| Number | Characteristic | Symbol | Min | Max | Min | Max | Min | Max | Unit |
| 1 | Cycle Time | t _{cyc} ` | 10 | 10 | 0 667 | 10 | 05 | 10 | μS |
| 2 | Pulse Witdth, E Low | PWEL | 430 | 9500 | 280 | 9500 | 210 | 9700 | ns |
| 3 | Pulse Width, E High | PWEH | 450 | 9500 | 280 | 9500 | 220 | 9700 | ns |
| 4 | Clock Rise and Fall Time | t _r , t _f | _ | 25 | _ | 25 | _ | 20 | ns |
| 5 | Pulse Width, Q High | PWQH | 430 | 5000 | 280 | 5000 | 210 | 5000 | ns |
| 6 | Pulse Width, Q Low | PWQL | 450 | 9500 | 280 | 9500 | 220 | 9500 | ns |
| 7 | E to Q Rise Delay Time* | tAVQ | - | 250 | _ | 165 | - | 125 | ns |
| 9 | Address Hold Time | tAH | 10 | _ | 10 | - | 10 | _ | ns |
| 13 | Address Setup Time Before E | tAS | 80 | - | 60 | - | 40 | - | ns |
| 14 | Chip Select Setup Time Before E | tcs | 80 | _ | 60 | _ | 40 | - | ns |
| 15 | Chip Select Hold Time | tCH | 10 | _ | 10 | _ | 10 | _ | ns |
| 18 | Read Data Hold Time | †DHR | 20 | 100 | 20 | 100 | 20 | 100 | ns |
| 21 | Write Data Hold Time | tDHW | 10 | - | 10 | - | 10 | _ | ns |
| 30 | Output Data Delay Time | tDDR | - | 290 | _ | 180 | - | 150 | ns |
| 31 | Input Data Setup Time | tDSW | 165 | _ | 80 | _ | 60 | _ | ns |
| See Figures 2 and 3 | Three-State Address Delay | ^t TAD | - | 90 | - | 80 | - | 60 | ns |
| See Figure 2 | Mapped Address Delay | ^t MAD | _ | 200 | _ | 145 | _ | 110 | ns |

^{*}At specified cycle time

FIGURE 1 - BUS TIMING R/W, Address (Non-Muxed) CS 30 Read Data MPU Read Data Non-Muxed Non-Muxed MPU Write Data Non-Muxed Write Data Non-Muxed

1 Voltage levels shown are VL \le 0 4 V, VH \ge 2 4 V, unless otherwise specified 2 Measurement points shown are 0 8 V and 2 0 V, unless otherwise specified





Note: Timing measurements are referenced to and from a low voltage of 0.8 volts and a high voltage of 2.0 volts, unless otherwise noted.

PIN DESCRIPTION

The following section describes each pin of the MMU in detail.

 V_{CC} , V_{SS} — Supplies power to the MC6829. V_{CC} is +5 volts and V_{SS} is ground.

E - Input E clock (from MC6809).

Q - Input Q clock (from MC6809).

 R/\overline{W} - Read/Write Line Input: 1 = Read, 0 = Write.

D0-D7 — Bi-directional Data Bus. The data bus is used when the MMU registers are to be read or written.

A11-A15 — Logical Address Lines (Input to MMU). The physical address lines are generated by the MMU for every bus cycle. When multiple MMUs are present in a system, only one MMU will output a physical address. Each physical address line will drive one Schottky TTL load or four TTL loads and a maximum of 90 pF.

PA11-PA20 — Physical Address Lines (Output from MMU). The physical address lines are generated by the MMU for every bus cycle. When multiple MMUs are present in a system, only one MMU will output a physical address Each physical address line will drive one Schottky TTL load or four LS TTL loads and a maximum of 90 pF.

RS0-RS6 — Register Select Lines (Access to MMU Registers). When accessing the MMU registers, the register select lines determine which byte of information is being referenced within the MMU. Valid addresses are detailed in the Register Select Truth Table.

 $BA,\,BS-$ Bus Available and Bus State (Inputs). These inputs are directly connected from the BA, BS lines of the MC6809. They provide the MMU with information about the class of bus operation for each cycle. Note that when coming out of a DMA cycle, the MC6809 BA, BS pins change back from DMA acknowledge (BA=1, BS=1) to running (BA=0, BS=0) one cycle before the end of the DMA.

RA — Register Access (Chip Select for MMU Registers). This active low input determines the location of the MMU registers. Since the MMU registers are only accessible from the last page of task #0 (\$F800-\$FFFF), this signal can be derived from address lines A10-A7 of the processor. When RA is asserted low, the MMU registers are selected if the current task number is zero and A15-A11 are all 1's.

 $\overline{\text{KVA}}$ — Key Value Access select line (Input). This active low input enables access to the 3-bit Key Value register on the MMU. Reading the Key Value Register is allowed only when the current task is zero, address lines A11-A15 are all ones, $\overline{\text{RA}} = 0$ (asserted), RS6-RS0 are within the range \$40-\$47 and $\overline{\text{KVA}} = 0$ (also asserted). Writing the Key Value Register has the additional requirement of having the S-bit set

RESET — RESET (Input). A low level on this input causes the MMU to initialize its registers to a known state. An internal flag is also set which forces \$3FF onto the physical address lines until the Key Value Register is written. RESET must be low for at least one cycle.

MMU OPERATION

For every processor cycle, the MMU supplies a mapped address based on the processor address and the current task number (refer to Figure 4). The current task number is kept in an on-chip register called the OPERATE KEY. Changing the value of the operate key causes a new map to be selected.* The MMU also contains automatic task switching logic to cause pre-defined task numbers to override the task number in the operate key for certain events (Interrupts, Direct Memory Access, Reset)

. The MMU registers always appear as a block of 64 byes located on the last page of task #0 (refer to Figure 5). When the registers are accessed, the MMU outputs a physical address of \$3FF (PA11-PA20 all high) This is necessary since the mapping RAM of the MMU cannot map an address and be modified at the same time.

The exact location of the MMU registers within the last page of physical memory is determined by the REGISTER ACCESS (RA) signal which is similar to a chip select line. The RA signal will normally be derived from processor address lines A7-A10 using a simple 4-input gate. For example, a 4-input NOR gate would place the MMU registers at \$F800 to \$F87F. In systems using DMA, the RA input must include the externally derived DMA/VMA signal to prevent dead bus cycles from affecting the MMU. Refer to Programming Con-

Inputs RS0-RS6 to the MMU are the register select lines. These lines are normally connected to the low order address lines A0-A6 from the processor. The MMU registers are only accessible if:

- 1. the current task number is zero;
- 2 processor address lines A11-A15 are all 1's.
- the Register Access line (RA) is asserted low;
- Register Select lines (RS0-RS6) contain a defined register address, and
- the System Bit (S-bit) is set (for a write operation only).

As a result of the above restrictions on accessing the MMU registers, the portion of the software that sets up and maintains the memory maps for all tasks must run as task zero.

The first 64 bytes of the MMU's register area comprise a "window" through which any one of the 4 maps may be viewed or changed. The task number to be viewed through this "window" is written into a read/write register called the ACCESS KEY Thus, to examine or change the map for any task, the processor must first write the task number into the Access Key. Once set, the Access Key will retain its value until explicitly changed

^{*}Refer to Register Select Truth Table for exact procedure to change this register

FIGURE 4 - LOGIC-TO-PHYSICAL ADDRESS TRANSLATION DIAGRAM

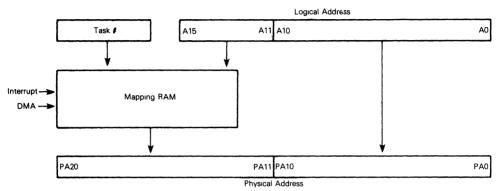
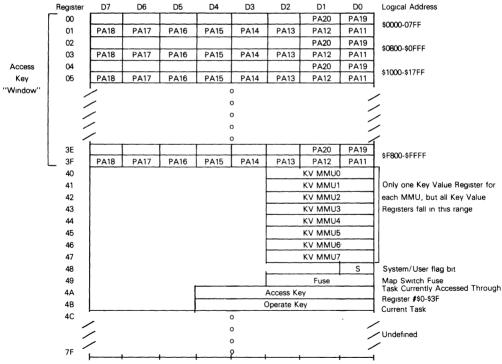


FIGURE 5 - MMU REGISTER MODEL



Notes

- 1 The contents of bytes \$4C through \$7F are undefined and do not respond to any reads or writes
- 2 The Access, Operate and Key Value Registers are cleared on reset. The S-bit is set
- 3 Unused bits of defined registers always read zeros
- 4. Locations \$40-\$47 are accessible only when $\overline{KVA} = 0$
- 5 In multiple MMU configurations, the MMU whose Key Value Register matches the upper three bits of the access key will respond to a processor read of locations \$48-\$4B Processor writes to these registers will cause the data to be written to all MMUs simultaneously

Pages in physical memory require 10 bits to define their location (refer to Figure 5). These 10 bits are arranged as a pair of bytes in the MMU in order to allow the use of double byte instructions (e.g., LDD) in manipulating the MMU registers. These first 64 bytes of the register area are then accessed as 32 pairs of bytes with each pair describing the logical-to-physical mapping for one 2K page. Registers 0 and 1 contain the page number for Igoical addresses \$0000-\$07FF, register 2 and 3 control logical addresses \$0800-\$07FF, etc.

Each MMU has a 3-bit register called the KEY VALUE REGISTER. This register determines the range of task numbers an MMU controls. The top three bits of the Operate Key must match the Key Value Register for that task to be active. Similarly, the Key Value Register must match the top three bits of the Access Key to change or view registers #0 through #\$3F. Each MMU must receive a unique key value when the system is initialized to guarantee that no two MMUs control the same range of tasks. To be able to write to each MMU's Key Value Register separately, an external decoder must be provided. This decode function can be derived from address lines A0, A1 and A2 using a 3-to-8 line decoder. Writing to locations \$40-\$47 will cause the Key Value of the MMU to be updated only if the KVA input is low. In systems using a single MMU, the KVA input may be wired low.

BUILDING AN MMU SYSTEM

Up to 8 chips may be connected in parallel to create a maximum of 32 tasks. All MMU pins except one (KVA) may be wired in parallel. Each MMU chip contains 1280 bits of fast on-chip lookup RAM. This RAM is accessible 10 bits at a time for mapping purposes, and as 2 and 8 bits at a time when the Operating System OS is changing the contents of the RAM. In addition to the lookup RAM, each MMU contains a separate copy of the Access Key, Operate Key, Fuse Register, Key Value Register, and S-bit, A CPU write to the Access, Operate, or Fuse Register causes all registers on all MMUs to be updated. In contrast, the lookup RAM for each chip is updated only when the top three bits of the Access Key match the Key Value Register for that chip. During mapping operations, each MMU compares the value in its Operate Key (top three bits) with its Key Value Register and responds only if a match is found. Similarly, when the processor reads the RAM, each MMU compares its Key value with the Access Key (Figure 6).

REGISTER SELECT TRUTH TABLE

.Table 1 shows how the MMU registers are accessed by the processor. It is assumed that the current task is zero and that the processor address lines A11-A15 are all ones. If the S-bit is not set, the registers are still readable, but cannot be modified.

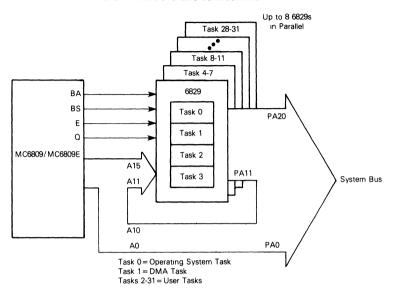
TABLE 1 - REGISTER SELECT TRUTH TABLE

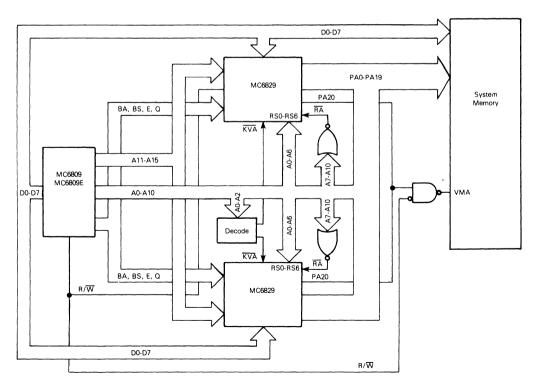
| | · | | | | | | | | | |
|----|-----|-----|-----|-----|-----|-------------|-----|-----|-----|---------------------------------|
| RA | R/W | KVA | RS6 | RS5 | RS4 | RS3 | RS2 | RS1 | RS0 | register addressed |
| 1 | х | × | × | х | × | × | × | х | × | none |
| 0 | × | 1 | 1 | 0 | 0 | 0 | × | × | × | none |
| 0 | 1 | 0 | 1 | 0 | 0 | 0 | X | X | X | read Key Value Register |
| 0 | 0 | 0 | 1 | 0 | 0 | 0 | × | × | Х | write Key Value Register |
| 0 | × | × | 0 | n | n | n | n | n | n | byte nnnnnn of MMU RAM (Note 1) |
| 0 | 0 | × | 1 | 0 | 0 | 1 | 0 | 0 | 0 | none (Note 2) |
| 0 | 0 | X | 1 | 0 | 0 | 1 | 0 | 0 | 1 | write Fuse Register |
| 0 |) 0 | X | 1 | 0 | 0 | 1 | 0 | 1 | 0 | write Access Key |
| 0 | 0 | × | 1 | 0 | 0 | 1 | 0 | 1 | 1 | write Operate Key |
| 0 | 1 | × | 1 | 0 | 0 | 1 | 0 | 0 | 0 | read S-bit (Note 3) |
| 0 | 1 | × | 1 | 0 | 0 | 1 | 0 | 0 | 1 | read Fuse Register (Note 3) |
| 0 | 1 | × | 1 | 0 | 0 | 1 1 | 0 | 1 | 0 | read Access Key (Note 3) |
| 0 | 1 | × | 1 | 0 | 0 | 1 | 0 | 1 | 1 | read Operate Key (Note 3) |
| | | | ١. | | | ١. | ١. | | | |
| 0 | X | × | 1 | 0 | 0 | 1 | 1 | X | X | none |
| 0 | X | X | l ! | 0 | 1 | X | X | X | X | none |
| 0 | X | × | , ' | 1 | × | X | X | X | X | none |

Notes

- 1 The MMU RAM is accessible only if the Key Value Register is equal to the top 3 bits of the Access Key Register. The lower two bits of the Access Key Register, then determines which task is to be accessed (R/W)
- 2 The S-bit is read-only
- 3 The S-bit, Fuse, Access or Operate registers are readable only if the Key Value Register is equal to the top 3 bits of the Access Key Register This insures that only one MMU will respond to a read request of these locations

FIGURE 6 - MMU SYSTEMS CONFIGURATION





REGISTER DESCRIPTION

System Bit (S-bit) — Read-only bit that must be set (S=1) to write MMU registers. Reset and Interrupts set the S-bit. Refer to Fuse Register for clearing the S-bit.

Operate Key — 5-bit R/W register that contains the current task number. The operate key retains its value until explicitly changed. During DMA transfers, the MMU overrides the value in the operate key and forces task #1 to be the active task. When the S-bit is set, the operate key is also overridden, and task #0 is forced to be the active key.

Key Value — 3-bit R/W register that contains the range of tasks an MMU controls. The Key Value Register must match the top three bits of the Operate Key for a task to be active. The KVA signal must be low for an access of this register.

Access Key - 5-bit R/\overline{W} register that contains the task number of a task to be viewed or changed. This register retains its value until explicitly changed

Register #0 to #3F — 64 bytes accessed as 32 pairs of bytes with each pair describing the logical to physical mapping for one 2K page. Refer to Figure 5.

Fuse Register — 3-bit count down register used to change from task #0 to a user task. When a write to this register is detected, the value written is loaded into the counter and it begins to decrement by one for every processor cycle. When the counter underflows, the S-bit is cleared and the next processor cycle will be mapped using the task number in the operate key.

RESET OPERATION

When reset, the MMU performs the following operations

- 1 The Key Value Register is cleared,
- 2 The Fuse Register is disabled,
- 3 The System bit (S-bit) is set,
- 4 The Operate Key Register is cleared,
- 5 The Access Key Register is cleared,
- 6 An internal reset flag is set

Reset causes the MC6829 to automatically switch the memory map to task #0 An internal flag is set causing all bus cycles to access physical addresses \$1FF800-\$1FFFF (PA11 to PA20 all high, page \$3FF) This flag is cleared when the Key Value Register is first written While the internal reset flag is set, each MMU in the system will be actively driving the address bus. An orderly start up procedure must assign each MMU a key value before individual task allocations are made.

FUSE REGISTER OPERATION

The Fuse Register is a 3-bit register used to switch from task #0 to any other task. A write to this register causes an internal 3-bit counter to be loaded with the data. On each successive valid (non-DMA) processor cycle the internal

counter is decremented once. When the counter reaches zero, the task number in the Operate Key will be the active task, mapping logical to physical address. The value written into the Fuse Register must be the number of cycles it takes to transfer program control from the store to Fuse Register instruction. It is the responsibility of the Operating System (task #0) to make sure the processor will execute code from the new task properly by changing the Program Counter the same cycle that the Fuse Register reaches zero (see following example)

Change from Task #0 to Task n

LDA #n STA OPERATE LDA #4 STA FUSE JMP \$XXXX

| Cycle | Write #4 to Fuse Register | 1 | Address High | Address Low | | Task N Opcode |
|---------------------------|---------------------------------|---|-----------------|----------------|---|------------------|
| Fuse Register Contents | 0 | 4 | 3 | 2 | 1 | 0 |

Refer to Section *MMU in a MC6809 System* for Fuse Register use in returning from an interrupt

MMU INITIALIZATION PROCEDURE

The following steps should be followed to initialize a multiple MMU system (Refer to Hardware/Programming Considerations, Programming Examples section)

- 1 Out of Reset, all MMUs are driving the address lines, PA11 to PA20, high This requires the initialization program to be located in this 2K byte page of physical memory Each MMU must be deselected by writing a unique value to its Key Value Register except for the MMU that will run task #0 (MMU0) MMU0's Key Value Register must not be written to until task #0 registers \$00 to \$3F are programmed, specifying the logical to physical mapping of memory In addition, if MMU0 Key Value Register is also initialized with a non-zero value at this time the entire memory space is deselected and the operating system (task #0) cannot be accessed (Example 1)
- 2 Only one MMU is now driving the address bus Task #0 memory pages (2K per page) must be assigned by writing the corresponding values into registers \$00 to \$3F (Example 2)
- 3 The Key Value Register must be written to MMU0's key value to allow initialization of all other tasks by removal of automatic mapping of PA11 to PA20 high (Example 2)
- 4 'At this time, each MMU has a unique key value, Task #0 has a specified memory map, and Task #0 is operating Tasks can now be started by writing the task number to be specified in the Access Key Register, writing registers \$00 to \$3F to the memory map desired, loading the program into memory and causing a task switch by a correct use of the Fuse Register

INTERRUPTS/MAP SWITCHING

The MC6829 monitors the Bus Available (BA) and Bus Status (BS) lines from the processor to determine what type of bus operation is occurring. When an interrupt is detected, the current task is overridden by Task #0. The map switch occurs during the processor vector fetch (BA = 0, BS = 1) so that Task #0 supplies the interrupt vector address. Detecting an interrupt also sets the S-bit within the MMU allowing Task #0 to be the operating task while the interrupt is serviced.

DMA OPERATION

For a DMA transfer, the memory map is switched to Task #1 This allows transfers of up to 64K bytes without processor intervention and without interfering with any other task. (An external DMA/ $\overline{\text{VMA}}$ signal should be included in the decode circuitry for the $\overline{\text{RA}}$ input to prevent dead bus cycles from affecting the MMU). At the end of the DMA transfer, the MC6829 returns to the task being used before the transfer began (refer to Programming Considerations)

MMU IN A MC6809 SYSTEM

The MC6829 is designed to work directly with the MC6809 processor. Other 8-bit microcomputers may also use the MMU by generating the appropriate inputs to the MMU. The crucial area for interfacing the computer to the MMU is the design of the map switching hardware.

For the MC6809, the BA and BS signals are extremely useful for this function. Decoding these two signals provides the following information.

| BA | BS | MC6809 State |
|----|----|------------------------------|
| 0 | 0 | Normal (running) mode |
| 0 | 1 | Interrupt Acknowledge (IACK) |
| 1 | 0 | SYNC Acknowledge |
| 1 | 1 | HALT or Bus Grant |

The MMU uses these two signals directly from the processor to determine what action to take for every bus cycle.

The MMU, unlike other M6800 peripherals, introduces an additional delay ($t_{\rm MAD}$) in the system configuration as it accepts address signals from the MPU and maps the MC6809 logical address to the system physical address. When a system is constructed this additional delay must be considered

The system clock frequency is determined by these address timing delays. Figure 7 shows this data. The System Cycle time may be determined by adding

- 1 the MPU E to Q rise delay tAVQ (max)
- 2 the MPU address valid to Q rise to tAQ (min)
- 3 the MMU mapping delay tMAD (max)
- 4 the system decode and buffer time tg (this is the delay due to bus buffers and decoding circuitry)
- 5 the address setup time required by peripherals tAS (note the setup time is required for the peripheral to determine if it is selected as well as deselected during every bus cycle!
- 6 the MPU pulse width high tPWEH

NOTE

This equation must be satisfied tpWEL≥tAVQ-tAQ+tMAD+tB+tAS

DMA OPERATION — By decoding the bus grant signal (BA=1, BS=1), the MMU will automatically switch to Task #1. Even when the MC6809 occasionally steals back a cycle to refresh its internal buses, this is reflected by a change in the bus grant signal which causes the map to temporarily switch back to the normal running mode

Note that the bus grant status is identical to the Halt status and is thus indistinguishable from a HALT. This should not cause a problem since halting the processor will simply cause the MMU to switch to Task #1. When the MC6809 starts to run again, the status lines will change and cause the MMU to switch to the proper map.

FIGURE 7 — ADDRESS DELAY

TPWEL 2

THAT I AND THAT I AN

4-365

CHANGING TASK TO OPERATING SYSTEM (OS) -

The OS map (Task #0) is automatically selected to service all interrupts. The Interrupt Acknowledge (IACK; BA=0, BS = 1) signal is used to determine when an interrupt vector is being fetched. The map is switched at this time in order to supply the processor with an interrupt vector from the OS address space, not the user's. At the time IACK is asserted, all of the registers have been stacked for the interrupt in the user's address map. This means that the only information the OS needs to save concerning the running process is its stack pointer. All other information about the task is saved on the user's stack and in the MMU registers. The map switch is latched since IACK will only be present for two machine cycles, yet the OS must retain control until the interrupt is serviced. This latched information is kept in a flag register called the S-bit. This bit is set on any IACK and remains set until cleared by software. The first thing the OS must do is save the interrupted task's stack pointer in a table and load the stack pointer with the current top of stack in the OS map. This is a critical section of code and must not be interrupted. For this reason, an MMU system cannot accept two interrupts in a row. The first interrupt causes the map to switch to task zero. The second interrupt would stack the machine state at the wrong address in the operating system As a consequence of this, Non-Maskable Interrupts (NMI) must be forbidden in multi-tasking systems since an NMI is possible at any time (even during another interrupt). Similarly, normal interrupts (IRQ) do not set the Fast Interrupt (FIRQ), bit F of the status register, in the processor and, thus, potentially allow another interrupt before the processor has a chance to switch stack pointers. Simple external hardware can be used to disable FIRQ when IRQ is pending. Unlike the NMI input, the FIRQ input is level sensitive and

may be masked with external hardware during IRQ operations.

A typical interrupt service routine begins like this:

ORCC #1+F STS SAVESP LDS OSSP

RETURNING FROM THE OS TO TASK N - The OS must execute an RTI instruction to get the processor to reload the user registers. The map switch must occur after the opcode for the RTI is fetched and before the first register is pulled from the stack. Prior to the RTI, the OS must reload the stack pointer from the one that corresponds to the task about to run. There must be no interrupts from the time the stack pointer is reloaded until the RTI is executed. The signal to the MMU that the map should be returned to the user task is noted by a write to a 3-bit down counter called the FUSE REGISTER. When a write to this register is detected, the value written is loaded into the counter and it begins to decrement by one for every processor cycle. When the counter under flows, the S-bit is cleared and the next processor cycle will be mapped using the task number in the Operate Key. For most systems, a 1 would be written to the Fuse Register immediately before the RTI opcode is executed. Note that DMA operations are still possible within this critical section. The Fuse Register counts only non-DMA cycles after the write to the Fuse Register in order to be sure of when to switch the map. Bus dead cycles are also excluded when clocking the Fuse Register. Thus, the Fuse Register is inhibited from counting whenever BA is high, and for the cycle after BA transitions from high to low. The common exit point for all OS functions looks something like this:

| EXIT | LDA | TASK | GET NEXT TASK TO RUN |
|------|------|--------|--------------------------------------|
| | STA | OPERAT | AND PLACE IT IN THE OPERATE KEY |
| | STS | OSSP | SAVE CURRENT STACK POINTER |
| | ORCC | #F+I | SET F AND I (ENTER CRITICAL SECTION) |
| | LDS | SAVESP | RESTORE USER'S STACK POINTER |
| | LDA | #1 | CAUSE MAP SWITCH 1 CYCLE AFTER |
| | STA | FUSE | WRITE TO FUSE REGISTER |
| | RTI | | RETURN TO USER TASK |
| | • | | |
| | _ | | |

MAP SWITCH OCCURS, USER TASK RESUMES

USING THE MC6800

When using a MC6800 processor external logic is required to determine when to switch maps. The MMU is controlled by its BA, BS inputs, the S-bit and the Operate Key. For example, deceding any references to the interrupt vectors and generating IACK as a result will work as long as each task references these locations only when the processor is fetching an interrupt vector. Another possibility is to monitor the processor R/W line. For the MC6800, the only time seven writes occur in a row is during an interrupt sequence. Thus the external logic that generates BA and BS must wait until it sees the seven writes and then assert IACK for the next two cycles.

A MC6800 processor interface to the MMU must also include logic to generate the Q bus signal.

HARDWARE/PROGRAMMING CONSIDERATIONS

The following sections contain examples and suggestions on how to apply the MMU in a system

MEMORY PROTECTION - The MMU can provide memory protection on a per page basis by defining the high order physical address line (PA20) as a write access line. If write protection is desired, this signal can be gated with the read/write line, from the processor, to generate a disable signal. This can be used to inhibit the memory chip select logic or generate an interrupt to signal a violation of a write protected area. The write protect line can also be combined with the DMA/VMA logic that is necessary in systems using DMA. In this case, writes to protected memory would appear as dead cycles to the main memory. Note that the designtion of the write protect line is purely arbitrary. The MMU simply combines the incoming address with the current task number to determine a 10-bit result. If no write protection is needed, PA20 can be used as a 21st address line, giving a total addressing range of 2 Megabyte This scheme can be reversed if desired and additional output lines from the MMU can be used to specify more attributes of the physical pages at the expense of reducing the number of pages in physical memory

MANAGING INTERRUPTS - An interrupt causes the processor to suspend the current running task and perform a service routine for the interrupting device. User programs should not have to handle interrupts directly. Thus on interrupts, the MMU (the operating system OS) must switch from the current map to task 0 so that it can handle the interrupt (The OS may of course elect to pass the work of handling a specific interrupt to a task that is expecting it.) The map switching is latched (indicated by the S-bit) so that the processor has as much time as it needs to service the interrupt After the interrupt has been processed, the OS can then look at the current process priorities and determine the next process to run If, after the interrupt service, the task that was running before the interrupt is to continue to run, the OS causes the map to switch back to that task. If, however, another task is to start running, the OS can simply write the new task number into the Operate Key Register and then cause the map switch. Returning to the normal map clears the S-bit and allows the user process to continue By supplying a source of periodic interrupts, the OS can regain control of the processor and reschedule running processes.

Operating system requests for privileged operations by running tasks are ideally handled using the SWI instruction. This causes a map switch to task zero (IACK is asserted on SWI) which then processes the request and eventually returns control to the requesting task. Note that SWI sets the I and F bits during execution of the instruction so that when the OS is entered, the critical section of saving the user task pointer and reloading the OS stack pointer can be safely executed. Note that SWI2 and SWI3 do not have this property and therefore require special handling. To safely use SWI2 or SWI3, the programmer must explicitly mask hardware interrupts.

ORCC #I+F DISABLE INTERRUPTS SWI2/3 CALL OS

MANAGING NON-EXISTENT MEMORY ACCESSES -

Memory accesses to non-existent memory requires careful consideration. Once an instruction has begun execution, there is no way to stop it from completing. Thus, an instruction may reference a non-existent memory location, or an interrupt may cause the machine state to be stacked into non-existent memory. Once this has occurred, there is not always enough information available to backtrack the last instruction.

One solution to this problem is a hardware FIFO When a task is initialized, a certain number of pages will be assigned from available memory. For example, a ROM program could be placed in a task's map along with RAM for stack and variable data areas. The remaining pages in the task's map are unassigned and references to these unassigned areas require special handling. These gaps in the memory map of a task may be filled by constructing a "FIFO page" that returns a known value when read (zero) and when written saves the (logical) address and the data written to it. If at any time the FIFO is not empty, the FIFO causes an interrupt at the end of the current instruction. The processor then examines the contents of the FIFO and allocates real pages where there were none before. The data in the FIFO is then placed in real memory and the task may resume execution. Thus, the program is stopped at the end of the instruction that causes a page fault, and all writes to non-existent memory are captured in the FIFO

The maximum number of new pages that may be required after any page fault is four. Consider the following instruction sequence. A task has just started running and has only one page allocated to it (\$0000-\$1FFF). The program to be executed is as follows.

| ORG | \$0000 | PROGRAM START ADDRESS |
|-----|---------|-----------------------|
| LDS | #\$8000 | INITIALIZE STACK |
| LDX | #\$3FFF | POINT TO DATA AREA |
| LDD | #\$1234 | |
| STD | .X | INITIALIZE VARIABLE |

Execution then proceeds as follows. Upon executing the fourth instruction, two bytes are written, one at location s3FFF and the other at \$4000. Since neither of these two pages actually exist, the FIFO catches the address and data written and pulls the IRQ line to signal a page fault. At the

end of the STD instruction, the processor will stack the machine registers which causes two further page faults since the stacking operation writes data to locations \$7FF5-\$8000. The FIFO must also catch these references since they contain the machine state at the time of the original interrupt. When task zero gains control, the FIFO data must be cleared before any attempt is made to reference the task's memory map. If there are no available pages, the task may be made inactive until sufficient space exists to allow the program to continue.

The maximum number of bytes that may be written to non-existent memory before task zero gains control is 24 This occurs when the task pushes all of its registers onto the stack when the stack points to an uninitialized page. Pushing all registers requires 12 bytes. At the end of the instruction, an interrupt will be generated which again pushes the entire machine state. Thus, the FIFO must be 24 bits wide (16 address+8 data lines) and 24 words deep

The primary benefit of this scheme is to allow the MC6809 stack to grow dynamically. When a task starts to run, the stack could be initialized to \$FFFF with no real memory at that location. When the task did its first subroutine call or

stack push, the FIFO interrupt would catch the information and the operating system would then allocate memory. If the task never used this area, it would remain unallocated and hus be available for other uses. Note that this approach provides for dynamic memory expansion of growing data areas. If the size of the static data areas is known at load-time, then memory can be allocated to a task as needed. Heap management (such as for an editor buffer) can be handled by task resident memory allocation routines which make operating system calls to obtain more heap space.

The FIFO scheme does not implement a demand paging system It is assumed that once a page has been assigned to a task the page remains assigned until the task ends execution or possibly gives it back (via a system call) to the operating system

DMA/VMA CIRCUIT

The following circuit, Figure 8 , is suggested to keep the MC6829 deselected during dead bus cycles of DMA. This circuit will also work in a non-MMU system.

RESET CLR CK 74LS74 D DMA/VMA

FIGURE 8 - M6809 DMA/VMA LOGIC

COMMON MMU EQUATES

Here is a list of assembler equates that are used in the following examples.

| MMU | EQU | \$F800 | START OF MMU REGISTERS (IN TASK 0) |
|--------|-----|------------|------------------------------------|
| MMUO | EQU | MMU + \$40 | FIRST MMU'S KEY VALUE REGISTER |
| MMU7 | EQU | MMU + \$47 | LAST MMU'S KEY VALUE REGISTER |
| SBIT | EQU | MMU + \$48 | SYSTEM/USER FLAG BIT |
| FUSE | EQU | MMU + \$49 | MAP SWITCH COUNT-DOWN REGISTER |
| ACCESS | EQU | MMU + \$4A | ACCESS.KEY |
| OPERAT | EQU | MMU + \$4B | OPERATE KEY |
| NTASK | EQU | 32 | NUMBER OF TASKS IN SYSTEM |
| NPAGE | EQU | 32 | NUMBER OF PAGES PER TASK |
| MAXPGE | EQU | \$400 | MAXIMUM NUMBER OF PAGES IN SYSTEM |
| PSIZE | EQU | 2048 | NUMBER OF BYTES IN A PAGE |

Programming Examples

Example #1 -

Write a program to initialize all MMU Key Value Registers except MMU0.

```
RESET ENTRY POINT FOR MMU SYSTEM

LDX #MMU7+1 POINT TO LAST MMU KEY VALUE REGISTER + 1
LDA #7 INITIALIZE VALUE

STA ,-X
DECA
BNE KVINIT

CONTINUE INITIALIZATION
```

At this point, each MMU will have a unique key value. Note that the Key Value Register for MMU0 has not yet been written so that page \$3FF is still on the physical address bus. The difference is that now only one MMU is driving the address bus.

Example #2 -

Write an initialization program that sets up the pages of Task #0 so that an address XXXX in Task #0 corresponds to physical address 1FXXXX

| | • | | |
|--------|---------------|----------------|--------------------------------------|
| | • | FROM KEY VA | LUE INITIALIZATION |
| • | • | | |
| • | NOW INITIALIZ | ZE IDENTITY MA | P FOR TASK 0 |
| • | | | |
| | CLR | ACCESS | TALK TO TASK 0 (ALREADY ZERO ANYWAY) |
| | LDX | #MMU | |
| | LDD | #\$3E0 | LAST PAGE -32 |
| MOINIT | STD | ,X + + | |
| | INCB | | QUIT WHEN D = \$200 |
| | BNE | MOINIT | |
| | CLR | MMU0 | LET MMU #0 GO |
| | JMP | EXBUG | TRANSFER TO MONITOR (EXBUG09) |

Example #3 -

Give task #9 physical page #88 and place it in the task's address space so that #9 refers to this page with addresses \$1000-\$17FF. Write protect this page for this task. (The write protect bit is defined as PA20 of the MMU.)

| PROTEC | EQU • | \$200 | WRITE PROTECT BIT POSITION (PA20) |
|--------|----------|--------------|-----------------------------------|
| | • | | |
| | • | | |
| | LDA | #9 | SELECT TASK #9 FOR |
| | STA | ACCESS | MODIFICATION |
| | LDX | #88 + PROTEC | WRITE PHYSICAL PAGE INTO |
| | STX | MMU + 4 | THE APPROPRIATE REGISTER |
| | • | | |

Example #4 -

Write a subroutine that reads a byte from any task. On entry, the A register contains the task number, and the X register contains the address of that task to read. Assume that the OS task has its third page free for this use. The byte that is read is returned in A.

| FPAGE FREE | EQU EQU | \$1000 4 | DEDICATED FREE PAGE OFFSET INTO MMU OF FPAGE |
|---------------|--------------------|---------------|---|
| : | FUBYTE - FE | TCH USER BYTE | |
| FUBYTE | LBSR LDA RTS | GETPAGE ,X | POINT TO PAGE PICKUP BYTE |

GET PAGE — POINT TO USER BYTE
 Given a task number in A and a task address in X, return with X pointing to that byte in task 0
 This subroutine assumes that task 0 has a free

Example #5 -

Write a subroutine that writes a byte to any task. On entry the A register contains the task number and the X register contains the address of that task to read. The B register contains the byte to place in the task's memory. Assume that the OS task has its third page free for this use.

| • | | |
|--------|----------|----------------------------------|
| • | SUBYTE - | SET USER BYTE |
| • | | |
| SUBYTE | LBSR | GETPAGE PLACE USER PAGE IN FPAGE |
| | STB | ,X |
| | RTS | |

Example #6 -

Write a subroutine to be given a task number and memory address that returns a pointer to that byte of the named task. On entry, the A register contains the task number and the X register contains the task address

* page (FPAGE) that it uses to map a page of the * specified task into task 0's map GETPAGE **PSHS** D, Y SAVE SOME REGISTERS STA ACCESS SETUP WINDOW TO TASK MOVE POINTER INTO ACCUMULATOR TFR X, D **ASRA** FIND PHYSICAL PAGE # ASRA ANDA #%00111110 MASK ALL BUT PAGE # LDY #MMU LDY A, Y PICKUP PAGE CLR ACCESS NOW TALK TO OS MAP 'FREE' OS PAGE STY MMU + FREE X, D NOW POINT TO OFFSET TFR ANDA #%111 MASK HIGH BITS OF ADDRESS #FPAGE POINT TO PAGE START LDX LEAX D, X ADD OFFSET D, Y, PC **PULS** RESTORE AND RETURN

The above method of fetching bytes from other tasks is appropriate where only a few bytes of memory are to be transferred. When larger amounts of memory are to be moved, a more general subroutine can be written that transfers up to 2K bytes (one page) before the MMU registers need to be changed.



MC6835 (1.0 MHz)

MC68A35 MC68B35 (2.0 MHz)

Advance Information

CRT CONTROLLER (CRTC)

The MC6835 is a ROM based CRT Controller which interfaces an MPU system to a raster scan CRT display. It is intended for use in MPU based controllers for CRT terminals in stand-alone or cluster configurations. The MC6835 supports two selectable mask programmed screen formats using the program select input (PROG).

The CRTC is optimized for the hardware/software balance required for maximum flexibility. All keyboard functions, reads, writes, cursor movements, scrolling, and editing are under processor control. The mask programmed registers of the CRTC are programmed to control the video format and timing.

- Cost Effective ROM Based CRTC Which Supports Two Screen Formats
- Useful in Monochrome or Color CRT Applications
- Applications Include "Glass-Teletype," Smart, Programmable, Intelligent CRT Terminals, Video Games, Information Displays
- Alphanumeric, Semigraphic, and Full Graphic Capability
- Timing May Be Generated for Almost Any Alphanumeric Screen Format, e g , 80 x 24, 72 x 64, 132 x 20
- Single +5 Volt Supply
- M6800 Compatible Bus Interface
- TTL-Compatible Inputs and Outputs
- Start Address Register Provides Hardware Scroll (By Page, Line, or Character)
- Programmable Cursor Register Allows Control of Cursor Position
- Refresh (Screen) Memory May Be Multiplexed Between the CRTC and the MPU Thus Removing the Requirements for Line Buffers or External DMA Devices
- Mask Programmable Interlace or Non-Interlace Scan Modes
- 14-Bit Refresh Address Allows Up to 16K of Refresh Memory for Use in Character or Semigraphic Displays
- 5-Bit Row Address Allows up to 32 Scan-Line Character Blocks
- By Utilizing Both the Refresh Addresses and the Row Addresses, a 512K Address Space is Available for Use in Graphics Systems
- Refresh Addresses are Provided During Retrace, Allowing the CRTC to provide Row Addresses to Refresh Dynamic RAMs
- Pin Compatible with the MC6845. The MC6845 May Be Used as a Prototype Part to Emulate the MC6835.

MAXIMUM RATINGS

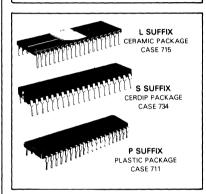
| Rating | Symbol | Value | Unit |
|--|-------------------|------------------------|------|
| Supply Voltage | vcc* | -03 to +70 | ٧ |
| Input Voltage | V _{in} * | -03 to +70 | ٧ |
| Operating Temperature Range MC6835, MC68A35, MC68B35 MC6835C, MC68A35C, MC68B35C | ТД | 0 to +70 -50 to +85 | ·°C |
| Storage Temperature Range | T _{stg} | -55 to +150 | °C |

^{*}With respect to GND (VSS)

MOS

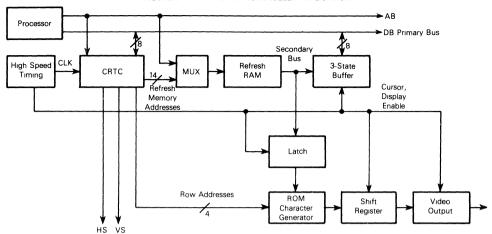
(HIGH-DENSITY, N-CHANNEL, SILICON-GATE DEPLETION LOAD)

MASK PROGRAMMED CRTC CONTROLLER (CRTC)



| GND | |
|-----------------------------|-----------------|
| RESET 0 2 | 39 T HS |
| PROGE 3 | 38 1 RAO |
| MA0 1 4 | 37 1 RA1 |
| MA1 D 5 | 36 T RA2 |
| MA2 [6 | 35 TRA3 |
| MA3 C 7 | 34 1 RA4 |
| MA4 [8 | 33 1 D0 |
| мА5 [9 | 32 D D1 |
| MA6 🕻 10 | 31 D D2 |
| MA7 [11 | 30 J D3 |
| MA8 🕻 12 | 29 1 D4 |
| MA9 [13 | 28 1 D5 |
| MA10 Д 14 | 27 1 D6 |
| MA11 [15 | 26 🗖 D7 |
| MA12 0 16 | 25 T CS |
| MA13 [17 | 24 1 RS |
| DE [18 | 23 D E |
| CURSOR 119 | 22 □ R/₩ |
| ∨ _{CC} I 20 | 21 1 CLK |

FIGURE 2 - TYPICAL CRT CONTROLLER APPLICATION



THERMAL CHARACTERISTICS

| Characteristic | Symbol | Value | Rating |
|--------------------|--------|-------|----------|
| Thermal Resistance | | | |
| Plastic | | 100 | l∘c/w |
| Cerdip | θJA | 60 | 1 °C/ VV |
| Ceramic | | 50 | |

RECOMMENDED OPERATING CONDITIONS

| Characteristic | Symbol | Min | Тур | Max | Unit |
|--------------------|--------|------|-----|------|------|
| Supply Voltage | Vcc | 4 75 | 50 | 5 25 | ٧ |
| Input Low Voltage | VIL | -03 | - | 0.8 | V |
| Input High Voltage | VIH | 20 | - | VCC | ٧ |

This device contains circuitry to protect the inputs against damage due to high static voltages or electric fields, however, it is advised that normal precautions be taken to avoid application of any voltage higher than maximum rated voltages to this high-impedance circuit. For proper operation it is recommended that V_{in} and V_{out} be constrained to the range $V_{SS}(\leq V_{in}$ or $V_{out}) \leq V_{CC}$. Reliability of operation is enhanced if unused inputs are tied to an appropriate logic voltage level (e.g., either V_{SS} or V_{CC})

POWER CONSIDERATIONS

The average chip-junction temperature, TJ, in °C can be obtained from

$$T_{J} = T_{A} + (P_{D} \bullet \theta_{JA})$$
Where

T_A ≡ Ambient Temperature, °C

 $\theta_{\rm JA} = {\rm Package\ Thermal\ Resistance,\ Junction-to-Ambient,\ ^{\circ}C/W}$

PD≡PINT+PPORT

PINT≡ICC×VCC, Watts - Chip Internal Power

PPORT≡Port Power Dissipation, Watts - User Determined

For most applications PPORT ◆PINT and can be neglected PPORT may become significant if the device is configured to drive Darlington bases or sink LED loads

An approximate relationship between PD and TJ (if PPORT is neglected) is

$$P_D = K + (T_J + 273 \,^{\circ}C)$$
 (2)

Solving equations 1 and 2 for K gives

 $K = PD \bullet (TA + 273 \circ C) + \theta_{JA} \bullet PD^{2}$ (3)

Where K is a constant pertaining to the particular part $\,$ K can be determined from equation 3 by measuring PD (at equilibrium) for a known TA $\,$ Using this value of K the values of PD and TJ can be obtained by solving equations (1) and (2) iteratively for any value of TA.

DC ELECTRICAL CHARACTERISTICS ($V_{CC} = 5.0 \text{ Vdc } \pm 5\%$, $V_{SS} = 0$, $T_A = 0 \text{ to } 70 ^{\circ}\text{C}$ unless otherwise noted) (Reference Figures 3-5)

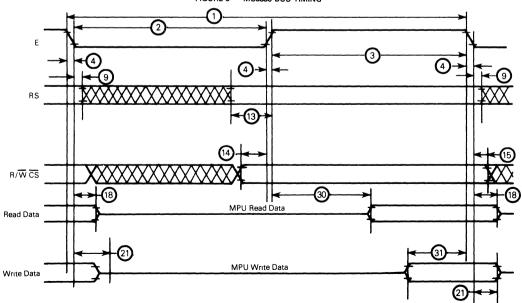
| Characteristic | Symbol | Min | Тур | Max | Unit |
|---|------------------|------|-----|------------|------|
| Input High Voltage | VIH | 2.0 | - | Vcc | ٧ |
| Input Low Voltage | VIL | -03 | - | 0.8 | V |
| Input Leakage Current | lin | - | 0.1 | 2.5 | μΑ |
| Three-State (V _{CC} = 5.25 V) (V _{IN} = 0.4 to 2 4 V) | ITSI | - 10 | - | 10 | μΑ |
| Output High Voltage $ (I_{\mbox{load}} = -205 \mu \mbox{A}) \qquad \qquad \mbox{D0-D7} $ $ (I_{\mbox{Load}} = -100 \mu \mbox{A}) \qquad \qquad \mbox{Other Outputs} $ | Voн | 2.4 | 3.0 | = | ٧ |
| Output Low Voltage (I _{load} = 1 6 mA) | VOL | _ | 0.3 | 04 | ٧ |
| Internal Power Dissipation (Measured at TA=TL) | PD | - | 600 | 750 | mW |
| Input Capacitance D0-D7 All Others | C _{in} | = | - | 12 5 10 | pF |
| Output Capacitance All Outputs | C _{out} | - | - | 10 | pF |

BUS TIMING CHARACTERISTICS (Reference Figures 3 and 4)

| ident. | Characteristics | C | MC6835 | | MC68A35 | | MC68B35 | | Unit |
|--------|---|---------------------------------|--------|------|---------|------|---------|------|------|
| Number | Characteristics | Symbol | Min | Max | Min | Max | Min | Max | Unit |
| 1 | Cycle Time | tcyc | 10 | 10 | 0 67 | 10 | 05 | 10 | μs |
| 2 | Pulse Width, E Low | | 430 | 9500 | 280 | 9500 | 210 | 9500 | ns |
| 3 | Pulse Width, E High | | 450 | 9500 | 280 | 9500 | 220 | 9500 | ns |
| 4 | Clock Transition Time | t _r , t _f | - | 25 | _ | 25 | _ | 20 | ns |
| 9 | Address Hold Time (RS) | tAH | 10 | _ | 10 | - | 10 | _ | ns |
| 13 | RS Setup Before E | tAS | 80 | _ | 60 | _ | 40 | _ | ns |
| 14 | R/W and CS Setup Before E | tcs | 80 | _ | 60 | _ | 40 | - | ns |
| 15 | Hold Time for R/W and CS | tCH | 10 | - | 10 | - | 10 | - | ns |
| 18 | Peripheral Read Data Hold Time Provided | tDDR | 20 | 50* | 20 | 50* | 20 | 50* | ns |
| 21 | Write Data Hold Time Required | tDHW | 10 | - | 10 | - | 10 | - | ns |
| 30 | Peripheral Output Data Delay | tDDR | _ | 290 | - | 180 | 0 | 150 | ns |
| 31 | Peripheral Input Data Setup | tDSW | 165 | _ | 80 | - | 60 | _ | ns |

^{*}The data bus output buffers are no longer sourcing or sinking current by tour max (high impedance)

FIGURE 3 - MC6835 BUS TIMING



CRTC TIMING CHARACTERISTICS (See Figure 5)

| Characteristics | Symbol | Min | Max | Unit |
|------------------------------------|-----------------------------------|-----|-----|------|
| Minimum Clock Pulse Width, Low | PWCL | 160 | _ | ns |
| Mınımum Clock Pulse Wıdth, High | PWCH | 200 | _ | ns |
| Clock Frequency | fc | _ | 25 | MHz |
| Rise and Fall Time for Clock Input | t _{cr} , t _{cf} | _ | 20 | ns |
| Memory Address Delay Time | tMAD | - | 160 | ns |
| Raster Address Delay Time | tRAD | - | 160 | ns |
| Display Timing Delay Time | tDTD | _ | 300 | ns |
| Horizontal Sync Delay Time | tHSD | _ | 300 | ns |
| Vertical Sync Delay Time | tvsD | - | 300 | ns |
| Cursor Display Timing Delay Time | tCDD | - | 300 | ns |

FIGURE 4 - BUS TIMING TEST LOAD

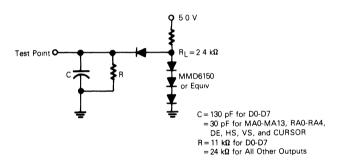
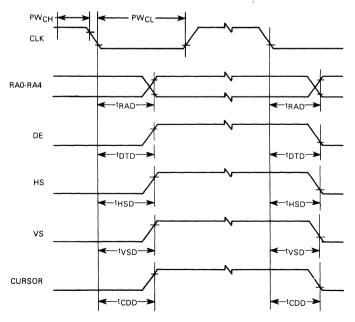


FIGURE 5 — CRTC TIMING CHART



NOTE Timing measurements are referenced to and from a low voltage of 0.8 volts and a high voltage of 2.6 volts unless otherwise noted

CRTC INTERFACE SYSTEM DESCRIPTION

The MC6835 CRT Controller generates the signals necessary to interface a digital system to a raster scan CRT display. In this type of display, an electron beam starts in the upper left hand corner, moves quickly across the screen and returns. This action is called a horizontal scan. After each horizontal scan the beam is incrementally moved down in the vertical direction until it has reached the bottom. At this point one frame has been displayed, as the beam has made many horizontal scans and one vertical scan.

Two types of raster scanning are used in CRTs, interlace and non-interlace, shown in Figures 6 and 7 Non-interlacing scanning consists of one field per frame. The scan lines in Figure 6 are shown as solid lines and the retrace patterns are indicated by the dotted lines. Increasing the number of frames per second will decrease the flicker. Ordinarily, either a 50 or 60 frame per second refresh rate is used to minimize beating between the frequency of the CRT horizontal oscillator and the power line frequency. This prevents the displayed data from weaving or swimming.

Interlace scanning is used in broadcast TV and on data monitors where high density or high resolution data must be displayed. Two fields, or vertical scans are made down the screen for each single picture or frame. The first field (Even

field) starts in the upper left hand corner, the second (Odd field) in the upper center. Both fields overlap as shown in Figure 7, thus interlacing the two fields into a single frame.

In order to display the characters on the CRT screen the frames must be continually repeated. The data to be displayed is stored in the Refresh (Screen) memory by the MPU controlling the data processing system. The data is usually written in ASCII code, so it cannot be directly displayed as characters. A Character Generator ROM is typically used to convert the ASCII codes into the "dot" pattern for every character.

The most common method of generating characters is to create a matrix of ''x'' dots (columns) wide and ''y'' dots (rows) high Each character is created by selectively filling in the dots As ''x'' and ''y'' get larger a more detailed character may be created Two common dot matrices are 5×7 and 7×9 Many variations of these standards will allow Chinese, Japanese, or Arabic letters instead of English Since characters require some space between them, a character block larger than the character is typically used as shown in Figure 8. The figure also shows the corresponding timing and levels for a video signal that would generate the characters

Active Display

Retrace

Vertical Scan Period

Vertical Retrace Period

Vertical Retrace Period

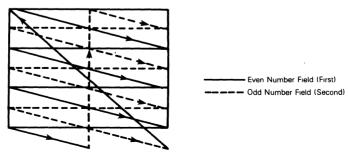
Period

Period

Period

FIGURE 6 - RASTER SCAN SYSTEM (NON-INTERLACE)

FIGURE 7 - RASTER SCAN SYSTEM (INTERLACE)



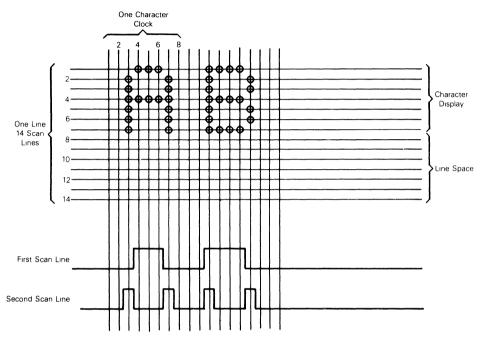


FIGURE 8 — CHARACTER DISPLAY ON THE SCREEN AND VIDEO SIGNAL

Referring to Figure 2, the MC6835 CRT controller generates the Refresh addresses (MA0-MA13), row addresses (RA0-RA4), and the video timing (vertical sync - VS, horizontal sync — HS and display enable — DE) Other functions include an internal cursor register which generates a Cursor output when its contents compare to the current Refresh address. A select input, PROG, allows selection of one of two mask programmed video formats (e.g., for 50 Hz and 60 Hz compatibility).

All timing in the CRTC is derived from the CLK input. In alphanumeric terminals, this signal is the character rate. The video rate or "dot" clock is externally divided by high speed logic (TTL) to generate the CLK signal. The high speed logic must also generate the timing and control signals necessary for the Shift Register, Latch and MUX Control shown in Figure 2.

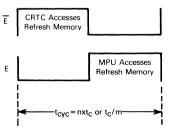
The processor communicates with the CRTC through an 8-bit data bus by writing into the five user programmable registers of the MC6835.

The Refresh memory address is multiplexed between the processor and the CRTC. Data appears on a secondary bus separate from the processor's bus. The secondary data bus concept in no way precludes using the Refresh RAM for other purposes. It looks like any other RAM to the processor. A number of approaches are possible for solving contentions for the Refresh memory.

 Processor always gets priority. (Generally, "hash" occurs as MPU and CRTC clocks are not synchronized.)

- 2 Processor gets priority access anytime, but can be synchronized by an interrupt to perform accesses only during horizontal and vertical retrace times
- 3 Synchronize the processor with memory wait cycles (states)
- 4 Synchronize the processor to the character rate as shown in Figure 9. The M6800 processor family works very well in this configuration as constant cycle lengths are present. This method provides no overhead for the processor as there is never a contention for a memory access. All accesses are transparent.

FIGURE 9 — TRANSPARENT REFRESH MEMORY CONFIGURATION TIMING USING M6800 FAMILY MPU



Where m, n are integers, to is character period

PIN DESCRIPTION

PROCESSOR INTERFACE

The CRTC interfaces to a processor bus on the bidirectional data bus (D0-D7) using \overline{CS} , RS, E, and R/ \overline{W} for control signals.

Data Bus (D0-D7) — The bidirectional data lines (D0-D7) allow data transfers between the internal CRTC register file and the processor. Data bus output drivers are high-impedance buffers which remain in the high-impedance state until the processor performs a CRTC read operation

Enable (E) — The Enable signal is a high-impedance TTL/MOS-compatible input which enables the data bus input/output buffers and clocks data to and from the CRTC. This signal is usually derived from the processor clock. The high-to-low transition is the active edge

Chip Select (CS) — The CS line is an active-low high-impedance TTL/MOS-compatible input which selects the CRTC to read or write to the internal register file. This signal should only be active when there is a valid stable address being decoded from the processor

Register Select (RS) — The RS line is a high-impedance TTL/MOS-compatible input which selects either the Address Register (RS = "0") or one of the Data Registers (RS = "1") of the internal register file when \overline{CS} is low

Read/Write (R/W) — The R/W line is a high-impedance TTL/MOS-compatible input which determines whether the internal register file gets written or read. A write is defined as a low level.

CRT CONTROL

The CRTC provides horizontal sync (HS), vertical sync (VS), and display enable (DE) signals.

NOTE — Care should be exercised when interfacing to CRT monitors as many monitors claiming to be "TTL compatible," have transistor input circuits which require the CRTC or TTL devices buffering signals from the CRTC/video circuits to exceed the maximum rated drive currents.

Vertical Sync (VS) and Horizontal Sync (HS) — These TTL-compatible outputs are active-high signals which drive the monitor directly or are fed to the video processing circuitry to generate a composite video signal. The VS signal determines the vertical position of the displayed text while the HS signal determines the horizontal position of the displayed text.

Display Enable (DE) — This TTL-compatible output is an active-high signal which indicates the CRTC is providing addressing in the active Display Area.

REFRESH MEMORY/CHARACTER GENERATOR ADDRESSING

The CRTC provides Memory Addresses (MA0-MA13) to scan the Refresh RAM. Row Addresses (RA0-RA4) are also provided for use with character generator ROMs. In a

graphics system both the Memory Addresses and the Row Addresses would be used to scan the Refresh RAM. Both the Memory Addresses and the Row Addresses continue frun during vertical retrace thus allowing the CRTC to provide the refresh addresses required to refresh dynamic RAMs.

Refresh Memory Addresses (MA0-MA13) — These 14 outputs are used to refresh the CRT screen with pages of data located within a 16K block of refresh memory. These outputs are capable of driving one standard TTL load and 30 pF

Row Addresses (RA0-RA4) — These five outputs from the internal Row Address counter are used to address the Character Generator ROM. These outputs are capable of driving one standard TTL load and 30 pF

OTHER PINS

Cursor — This TTL-compatible output indicates a valid Cursor address to external video processing logic. It is an active-high signal

Clock (CLK) — The CLK is a TTL/MOS-compatible input used to synchronize all CRT functions except for the processor interface An external dot counter is used to derive this signal which is usually the character rate in an alphanumeric CRT The active transition is high-to-low.

Program Select (PROG) — This TTL-compatible input allows selection of one of two sets of mask programmed video formats. Set zero is selected when PROG is low and set one is selected when PROG is high

V_{CC}, GND - These inputs supply +5 Vdc $\pm5\%$ to the CRTC.

RESET — The RESET input is used to reset the CRTC. Functionality of RESET differs from that of other M6800 parts RESET must remain low for at least one cycle of the character clock (CLK) A low level on the RESET input forces the CRTC into the following state:

- All counters in the CRTC are cleared and the device stops the display operation.
- b All the outputs are driven low, except the MA0-MA13 outputs which are driven to the current value in the Start Address Register.
- The control registers of the CRTC are not affected and remain unchanged.
- d. The CRTC resumes the display operation immediately after the release of RESET.

CRTC DESCRIPTION

The CRTC consists of mask-programmable horizontal and vertical timing generators, software-programmable linear address register, mask-programmable cursor logic and control circuitry for interfacing to a M6800 family microprocessor buse.

All CRTC timing is derived from CLK, usually the output of an external dot rate counter. Coincidence (CO) circuits continuously compare counter contents to the contents of the

RS Address Register Register Program Number of Bits cs Write Register File Read 6 5 4 3 2 1 Unit XXXXX X x 0 X X X X X 0 AR Address Register Nο Yes Horizontal Total RO Char No No R1 Horizontal Displayed Char No No R2 H Sync Position Char No No Note 3 R3 Sync Width Nο No V V ٧ Н ннн R4 Vertical Total Char Row No No R5 V Total Adjust Scan Line No No No R6 Vertical Displayed Char Row Nο R7 V Sync Position Char Row Nο Nο С D R8 Interlace Mode and Skew Note 1 No No П R9 Max Scan Line Address No Scan Line No R10 Cursor Start Scan Line No В Р R11 Cursor End Scan Line No No 0 1 1 0 0 R12 Start Address (H) No Yes 0 0 0 1 0 1 0 1 1 0 1 R13 Start Address (L) Nο Yes __ 0 1 0 1 1 1 0 0 R14 Cursor (H) No 0 Yes 0 1 0 1 1 1 1 R15 Cursor (L) No Yes

TABLE 1 - INTERNAL REGISTER ASSIGNMENT

NOTES

- 1 The Interlace Control is shown in Table 2 while Skew Control is shown in Table 3
- 2. Bit 5 of the Cursor Start Raster Register is used to blink period control, and Bit 6 is used to select blink or non-blink
- 3 R0-R11 are mask-programmable and are not accessible via the data bus

mask programmable register file, R0-R11 For horizontal timing generation, comparisons result in

- Horizontal sync pulse (HS) of a frequency, position and width determined by the register contents
- 2 Horizontal Display signal of a frequency, position and duration determined by the register contents

The horizontal counter produces H clock which drives the Scan Line Counter and Vertical Control. The contents of the Raster Counter are continuously compared to the Max Scan Line Address Register. A coincidence resets the Raster Counter and clocks the Vertical Counter.

Comparisons of Vertical Counter contents and Vertical Registers result in

- 1. Vertical sync pulse (VS) of a frequency, position and width determined by the register contents.
- 2. Vertical Display signal of a frequency, position, and duration determined by the register contents.

The Vertical Control Logic has other functions

- Generate row selects, RA0-RA4, from the Raster Count for the corresponding interlace or non-interlace modes
- Extend the number of scan lines in the vertical total by the amount programmed in the Vertical Total Adjust Register.

The cursor logic determines the size and blink rate of the

cursor as indicated by the register contents

The Linear Address Generator is driven by CLK and locates the relative positions of characters in memory and their positions on the screen Fourteen outputs, MA0-MA13, are available for addressing up to four pages of 4K characters, eight pages of 2K characters, etc

Five additional write-only registers define the Start Address and cursor position. Using the Start Address Register, hardware scrolling through 16K characters is possible. The Linear Address Generator repeats the same sequence of addresses for each scan line of a character row. The Start Address Register and the Cursor Position Register are programmed by the processor through the data bus, D0-D7 and the control signals — R/W, \overline{CS} , RS, and E. Refer to Figure 10

REGISTER FILE DESCRIPTION

The MC6835 has 17 control registers of which 12 are mask programmable. The remaining five registers — Address register, Start Address register pair, and Cursor Position register pair. — are write-only registers programmed by the MPU These registers control horizontal timing, vertical timing, interlace operation, row address operation and define the cursor, cursor address, start address and light pen register. The register addresses and sizes are shown in Table 1.

V_{CC} GND Prog R/W CS RS E RESET DO-D7 + + + + Address Register and Decoder со Horizontal CTR (± 256) CLKсо Reg H Display Horizontal Displaye Reg СО CE Horizontal HS-Sync Position Reg Sync Width CTR (-16) CLK →HS Horizontal Sync Width Register со Character Row CTR (- 128) co Vertical Total Reg Vertical Total Adjust Register V Display Vertical Control СО нн--Reg Position Reg → vs Interlace Mode Reg Scan Line CTR (- 32) со Address Reg Cursor Control **→**CURSOR Cursor End Reg Start Address Reg Linear Address CLK-Generator со **₩** MA0-MA13 RAO-RA4

FIGURE 10 - CRTC BLOCK DIAGRAM

MASK PROGRAMMABLE REGISTERS RO-R11

The twelve mask programmable registers determine the display format generated by the MC6835. The PROG input is used to select one of two sets of register values.

Figure 11 shows the visible display area of a typical CRT monitor giving the point of reference for horizontal registers as the left most displayed character position. Horizontal registers are programmed in character clock time units with respect to the reference as shown in Figure 12. The point of reference for the vertical registers is the top character position displayed. Vertical registers are programmed in character row times or scan line times as shown in Figure 13.

Horizontal Total Register (R0) — This 8-bit register determines the horizontal sync (HS) frequency by defining the HS period in character times. It is the total of the displayed characters plus the non-displayed character times (retrace) minus one

Horizontal Displayed Register (R1) — This 8-bit register determines the number of displayed characters per line. Any 8-bit number may be programmed as long as the contents of R0 are greater than the contents of R1.

Horizontal Sync Position Register (R2) — This 8-bit register controls the HS position. The horizontal sync position defines the horizontal sync delay (Front Porch) and the horizontal scan delay (Back Porch). When the programmed value of this register is increased, the display on the CRT screen is shifted to the left. When the programmed value is

decreased the display is shifted to the right. Any 8-bit number may be programmed as long as the sum of the contents of R1, R2, and the lower four bits of R3 are less than the contents of R0

Sync Width Register (R3) — This 8-bit register determines the width of the vertical sync (VS) pulse and the horizontal sync (HS) pulse Programming the upper four bits for 1-to-15 will select VS pulse widths from 1-to-15 scan-line times. Programming the upper four bits as zeros will select a VS pulse width of 16 scan line times. The HS pulse width may be programmed from 1-to-15 character clock periods thus allowing compatibility with the HS pulse width specifications of many different monitors. If zeros are written into the lower four bits of this register, then no HS is provided.

Horizontal Timing Summary (Figure 12) — The difference between R0 and R1 is the horizontal blanking interval. This interval in the horizontal scan period allows the beam to return (retrace) to the left side of the screen. The retrace time is determined by the monitor's horizontal scan components. Retrace time is less than the horizontal blanking interval. A good rule of thumb is to make the horizontal blanking about 20% of the total horizontal scanning period for a CRT. In inexpensive TV receivers, the beam overscans the display screen so that aging of parts does not result in underscanning. Because of this, the retrace time should be about 1/3 the horizontal scanning period. The horizontal sync delay, HS pulse width and horizontal scan delay are typically programmed with 1.2.2 ratio.

Number of Horizontal Total Char (Nht+1)

Number of Horizontal Displayed Char (Nhd)

I A B C

Number of Horizontal Displayed Char (Nhd)

Number of Horizontal Displayed Char (Nhd)

Horizontal Retrace Period

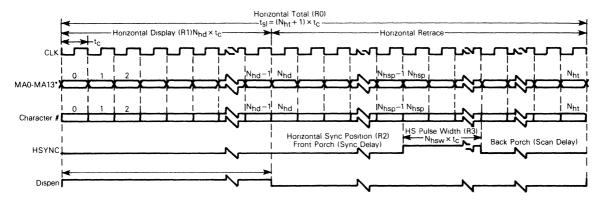
Vertical Retrace Period

FIGURE 11 - ILLUSTRATION OF THE CRT SCREEN FORMAT

Note 1 Timing values are described in Table 8

Total Scan Line Adjust (Nadj)-

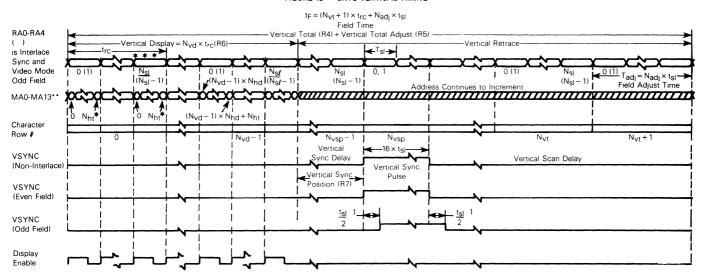
FIGURE 12 - CRTC HORIZONTAL TIMING



^{*}Timing is shown for first displayed scan row only See Chart in Figure 16 for other rows. The initial MA is determined by the contents of Start Address Register, R12/R13. Timing is shown for R12/R13=0.

Note 1: Timing values are described in Table 5

FIGURE 13 - CRTC VERTICAL TIMING



- *Nht must be an odd number for both interlace modes
- **Initial MA is determined by R12/R13 (Start Address Register), which is zero in this timing example
- ***N_{SI} must be an odd number for Interlace Sync and Video Mode

NOTES

- 1 Refer to Figure 7 The Odd Field is offset ½ horizontal scan time
- 2 Timing values are described in Table 5

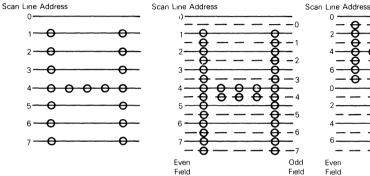
TABLE 2 - INTERLACE MODE REGISTER

| Bit 1 | Bit 0 | Mode |
|-------|-------|----------------------------------|
| 0 | 0 | Name of Control (Name) |
| 1 | 0 | Normal Sync Mode (Non-Interlace) |
| 0 | 1 | Interlace Sync Mode |
| 1 | 1 | Interlace Sync and Video Mode |

TABLE 3 - CURSOR START REGISTER

| | Bit 6 | Bit 5 | Cursor Display Mode |
|---|-------|-------|------------------------|
| | 0 | 0 | Non-Blink |
| i | 0 | 1 | Cursor Non-Display |
| i | 1 | 0 | Blink, 1/16 Field Rate |
| | 1 | 1 | Blink, 1/32 Field Rate |

FIGURE 14 - INTERLACE CONTROL



Odd Field

a) Normal Sync

b) Interlace Sync

c) Interlace Sync and Video

Vertical Total Register (R4) and Vertical Total Adjust Register (R5) - The frequency of VS is determined by both R4 and R5. The calculated number of character line times is usually an integer plus a fraction to get exactly a 50 or 60 Hz vertical refresh rate. The integer number of character line times minus one is programmed in the 7-bit Vertical Total Register (R4) The fraction of character line times is programmed in the 5-bit Vertical Total Adjust Register (R5) as a number of scan line times.

Vertical Displayed Register (R6) - This 7-bit register specifies the number of displayed character rows on the CRT screen, and is programmed in character row times. Any number smaller than the contents of R4 may be programmed into R6.

Vertical Sync Position (R7) - This 7-bit register controls the position of vertical sync with respect to the reference. It is programmed in character row times. The value programmed in the register is one less than the number of computed character line times. When the programmed value of this register is increased, the display position of the CRT screen is shifted up. When the programmed value is decreased the display position is shifted down. Any number equal to or less than the vertical total (R4) may be used

Interlace Mode and Skew Register (R8) - This 6-bit register controls the interlace modes and allows a programmable delay of zero to two character clock times for the DE (display enable) and Cursor outputs. Table 2 shows the interlace modes available to the user. These modes are selected using the two low order bits of this 6-bit register.

Table 4 describes operation of the Cursor and DE skew bits Cursor skew is controlled by bits 6 and 7 of R8 while DE skew is controlled by bits 4 and 5

In the normal sync mode (non-interlace) only one field is available as shown in Figures 6 and 14a. Each scan line is refreshed at the VS frequency (e.g., 50 or 60 Hz)

Two interlace modes are available as shown in Figures 7, 14b, and 14c. The frame time is divided between even and odd alternating fields. The horizontal and vertical timing relationship (VS delayed by 1/2 scan line time) results in the displacement of scan lines in the odd field with respect to the even field

In the Interlace Sync mode the same information is painted in both fields as shown in Figure 14b. This is a useful mode for filling in a character to enhance readability

In the Interlace Sync and Video mode alternating lines of the character are displayed in the even field and the odd field. This effectively doubles the number of characters that may be displayed on a CRT monitor of a given bandwidth.

Care must be taken when using either interlace mode to avoid an apparent flicker effect. This flicker effect is due to the doubling of the refresh period for all scan lines since each field is displayed alternately. Flicker may be minimized with proper monitor design (e.g., longer persistence phosphors).

In addition, there are restrictions on the programming of the CRTC registers for interlace operation:

- a. The Horizontal Total Register value, R0, must be odd (i.e., an even number of character times)
- b. For the Interlace Sync and Video mode only, the Vertical Displayed Register (R6) must be even. The programmed number, Nvd, must be 1/2 the actual number required.

TABLE 4 - CURSOR AND DE SKEW CONTROL

| Value | Skew |
|-------|--------------------|
| 00 | No Character Skew |
| 01 | One Character Skew |
| 10 | Two Character Skew |
| 11 | Not Available |

Maximum Scan Line Address Register (R9) — This 5-bit register determines the number of scan lines per character row including the spacing thus controlling operation of the Row Address counter. The programmed value is a maximum address and is one less than the number of scan lines

Cursor Start Register (R10) and Cursor End Register (R11)

— These registers allow a cursor of up to 32 scan lines in height to be placed on any scan line of the character block as shown in Figure 15 R10 is a 7-bit register used to define the start scan line and blink rate for the cursor Bits 5 and 6 of the Cursor Start Address Register control the cursor operation as shown in Table 4 Non-display, display and two blink modes (16 times or 32 times the field period) are available R11 is a 5-bit register which defines the last scan line of the cursor.

When an external blink feature on characters is required, it may be necessary to perform cursor blink externally so that both blink rates are synchronized. Note that an invert/non-invert cursor is easily implemented by programming the CRTC for a blinking cursor and externally inverting the video signal with an exclusive-OR gate.

PROGRAMMABLE REGISTERS

The five programmable registers allow the MPU to posi-

tion the cursor anywhere on the screen and allow the start address to be modified

The Address Register is a five-bit write-only register used as an ''indirect'' or ''pointer'' register. Its contents are the address of one of the other 18 registers. When both RS and $\overline{\text{CS}}$ are low, the Address Register is selected. When $\overline{\text{CS}}$ is low and RS is high, the register pointed to by the Address Register is selected.

Start Address Register (R12-H, R13-L) — This 14-bit write-only register pair controls the first address output by the CRTC after vertical blanking. It consists of an 8-bit low order (MA0-MA7) register and a 6-bit high order (MA8-MA13) register. The start address register determines which portion of the refresh RAM is displayed on the CRT screen. Hardware scrolling by character, line or page may be accomplished by modifying the contents of this register.

Cursor Register (R14-H, R15-L) — This 14-bit write-only register pair is programmed to position the cursor anywhere in the refresh RAM area thus allowing hardware paging and scrolling through memory without loss of the original cursor position. It consists of an 8-bit low order (MA0-MA7) register and a 6-bit high order (MA8-MA13) register.

CRTC INITIALIZATION

Registers R12-R15 must be initialized after the system is powered up. The processor will normally load the CRTC register file from a firmware table. Figure 16 shows an M6800 program which could be used to program the CRT Controller.

ADDITIONAL CRTC APPLICATIONS

The foremost system function which may be performed by the CRTC controller is the refreshing of dynamic RAM. This is quite simple as the refresh addresses continually run.

Both the VS and the HS outputs may be used as a real time clock. Once programmed, the CRTC will provide a stable reference frequency.

SELECTING MASK PROGRAMMED REGISTER VALUES

A prototype system may be developed using the MC6845 CRTC. This will allow register values to be modified as re-

quired to meet system specifications. The worksheet of Table 5 is extremely useful in computing proper register values for the MC6835. The program shown in Figure 16 may be expanded to properly load the calculated register values in the MC6845. Once the two sets of register values have been developed, fill out the ROM program worksheet of Figure 19.

To order a custom programmed MC6835, contact your local field service office, local sales person or your local Motorola representative A manufacturing mask will be developed for the data entered in Figure 19

FIGURE 16 - M6800 PROGRAM FOR CRTC INITIALIZATION

| PAGE ØØ1 CRTCINIT.SA:1 | MC6835 CRTC initia | lization program |
|--|---------------------|---|
| 00001 00002 00003 00004 *** | | itialization program =85 print FCB'x, FDB's & XREF table |
| | ssign CRTC address | |
| 00006 * | | |
| 00007 9000 A CRT | CAD EQU \$9000 | Address Register |
| | CRG EQU CRTCAD+ | |
| 00009 *** | ****** | ******** |
| | nitialization Prog | ram |
| 00011 * | | |
| 00012A 0000 | ORG Ø | a place to start |
| 00013A 0000 C6 0C A | LDAB \$C | initialize pointer |
| 00014A 0002 CE 1020 A | LDX 38RTTAB | • |
| 00015A 0005 F7 9000 A CRT | | load address register |
| ØØØ16A ØØØ8 A6 ØØ A | LDAA Ø,X | get register value from table |
| 00017A 000A B7 9001 A | STAA CRTCRG | program register |
| 00018A 000D 08 | INX | increment counter |
| 00019A 000E 5C | INCB | Civi-h-An |
| 00020A 000F D1 10 A | CMPB \$10 | finished? |
| 00021A 0011 26 F2 0005 | BNE CRTC1 | no: take branch |
| 00022A 0013 3F | SWI | yes: call monitor |
| 00023 | | |
| 00024 * C 00025 * | RTC register initia | allzation table |
| 00025 " 00026A 1020 | ORG \$1020 | start of table |
| 00027A 1020 0080 A CRT | | R12, R13 - Start Address |
| 00027A 1020 0080 A CRI 00028A 1022 0080 A | FDB \$0080 | R14, R15 - Cursor Address |
| 00028A 1022 0080 A 00029 | END SUUGU | ATT, ATT - CUISOI Address |
| TOTAL ERRORS ØØØØØØØØØØ | END | |
| TOTAL EVVOVO ANABALANDA | | |

CRTC1 0005 CRTCAD 9000 CRTCRG 9001 CRTTAB 1020

TABLE 5 - CRTC FORMAT WORKSHEET

Display Format Worksheet CRTC Registers

| 1 | Displayed Characters | per Row | | Char | | | Decimal | Hex |
|--------|--|----------------------------|------|-----------------|----------|---|---------|-----|
| 2 | Displayed Character | Rows per Screen | | Rows | B0 | Horizontal Total (Line 15 – 1) | | |
| 3 | Character Matrix | a Columns b Rows | | Columns Rows | | Horizontal Displayed (Line 1) Horizontal Sync Position (Line 1 + Line 12) | | |
| 4 | Character Block | a Columns b Rows | | Columns Rows | R3 | Horizontal Sync Width (Line 13) Vertical Total (Line 9 – 1) | | |
| 5 6 | Frame Refresh Rate Horizontal Oscillator | Frequency | | Hz Hz | R5 | Vertical Adjust (Line 9 Lines) | | |
| 7 | Active Scan Lines (L | ine 2× Line 4b) | | Lines | | Vertical Displayed (Line 2) Vertical Sync Position (Line 2+ Line 10) | | |
| 8 9 | Total Scan Lines (Lin Total Rows Per Scre | | Rows | Lines and Lines | R8 | Interlace (00 Normal, 01 Interlace, 03 Interlace, and Video) | | |
| 10 | Vertical Sync Delay | (Char Rows) | | Rows | R9 | Max Scan Line Add (Line 4b - 1) | | |
| 11 | Vertical Sync Width | (Scan Lines (16)) | | Lines | R10 | Cursor Start | | |
| 12 | Horizontal Sync Dela | y (Character Times) | | Char Times | R11 | Cursor End | | |
| 13 | Horizontal Sync Wid | th (Character Times) | | Char Times | R12, R13 | Start Address (H and L) | | |
| 14 | Horizontal Scan Dela | y (Character Times) | | Char Times | R14, R15 | Cursor (H and L) | | |
| 15 | Total Character Time | es (Line 1 + 12 + 13 + 14) | | Char Times | | | | |
| 16 | Character Rate (Line | 6 × 15) | | Hz | | | | |
| 17 | Dot Clock Rate (Line | • 4a × 16) | | Hz | | | | |

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TABLE 6 - WORKSHEET FOR 80×24 FORMAT

Display Format Worksheet

CRTC Registers

| 1 | Displayed Characters per Row | 80 Char | | Decimal | Hex |
|----|---|---------------------|--|---------|-----|
| 2 | Displayed Character Rows per Screen | Rows | R0 Horizontal Total (Line 15 minus 1) | 101 | 65 |
| 3 | Character Matrix a Columns | 7 Columns | R1 Horizontal Displayed (Line 1) | 80 | 50 |
| 4 | b Rows Character Block a Columns | 9 Rows 9 Columns | R2 Horizontal Sync Position (Line 1+ Line 12) | 86 | 56 |
| - | b Rows | Columns | R3 Horizontal Sync Width (Line 13) | 9 | 9 |
| 5 | Frame Refresh Rate | Hz | R4 Vertical Total (Line 9 minus 1) | 24 | 18 |
| 6 | Horizontal Oscillator Frequency | 18,600 Hz | R5 Vertical Adjust (Line 9 Lines) | 10 | A0 |
| 7 | Active Scan Lines (Line 2× Line 4b) | 264 Lines | R6 Vertical Displayed (Line 2) | 24 | 18 |
| 8 | Total Scan Lines (Line 6 – Line 5) | 310 Lines | R7 Vertical Sync Position (Line 2+ Line 10) | 24 | 18 |
| 9 | Total Rows Per Screen (Line 8 – Line 4b) | 28 Rows and 2 Lines | R8 Interlace (00 Normal, 01 Interlace, 03 Interlace, and Video) | | 0 |
| 10 | Vertical Sync Delay (Char Rows) | Rows | R9 Max Scan Line Add (Line 4b minus 1) | 11 | В |
| 11 | Vertical Sync Width (Scan Lines (16)) | 16 Lines | R10 Cursor Start | 0 | 0 |
| 12 | Horizontal Sync Delay (Character Times) | 6 Char Times | R11 Cursor End | 11 | В |
| 13 | Horizontal Sync Width (Character Times) | 9 Char Times | R12, R13 Start Address (H and L) | 128 | 00 |
| 14 | Horizontal Scan Delay (Character Times) | 7 Char Times | | | 80 |
| 15 | Total Character Times (Line 1 + 12 + 13 + 14) | 102 Char Times | R14, R15 Cursor (H and L) | 128 | 00 |
| 16 | Character Rate (Line 6 times 15) | 1 8972 M MHz | THE, THE CUISOF HE AND LE | | 80 |
| 17 | Dot Clock Rate (Line 4a times 16) | 17 075 M MHz | | | |

OPERATION OF THE CRTC

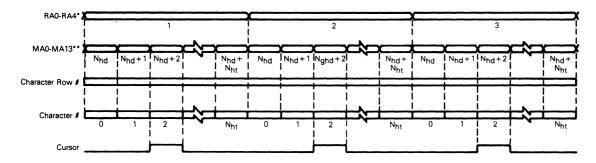
Timing of the CRT Interface Signals — Timing charts of CRT interface signals are illustrated in this section with the aid of programmed example of the CRTC. When values listed in Table 7 are programmed into CRTC control registers, the device provides the outputs as shown in the Timing Diagrams (Figures 12, 13, 17, and 18). The screen

format of this example is shown in Figure 11. Figure 18 is an illustration of the relation between Refresh Memory Address (MAO-MA13), Raster Address (RAO-RA4) and the position on the screen. In this example, the start address is assumed to be "O"

TABLE 7 - VALUES PROGRAMMED INTO CRTC REGISTERS

| Register Number | Register Name | Value | Programmed Value |
|--------------------|-----------------------|---------------------|---------------------|
| R0 | H Total | N _{ht} +1 | N _{ht} |
| R1 | H Displayed | N _{hd} | N _{hd} |
| R2 | H Sync Position | N _{hsp} | N _{hsp} |
| R3 | H Sync Width | N _{hsw} | N _{hsw} |
| R4 | V Total | N _{vt} + 1 | N _{Vt} |
| R5 | V Scan Line Adjust | N _{adj} | Nadj |
| R6 | V Displayed | N _{vd} | N _{vd} |
| R7 | V Sync Position | N _{vsp} | N _{vsp} |
| R8 | Interlace Mode | | |
| R9 | Max Scan Line Address | N _{sl} | N _{sl} |
| R10 | Cursor Start | | |
| R11 | Cursor End | | |
| R12 | Start Address (H) | 0 | |
| R13 | Start Address (L) | 0 | |
| R14 | Cursor (H) | | |
| R15 | Cursor (L) | | |
| R16 | Light Pen (H) | | |
| R17 | Light Pen (L) | | |

FIGURE 17 - CURSOR TIMING



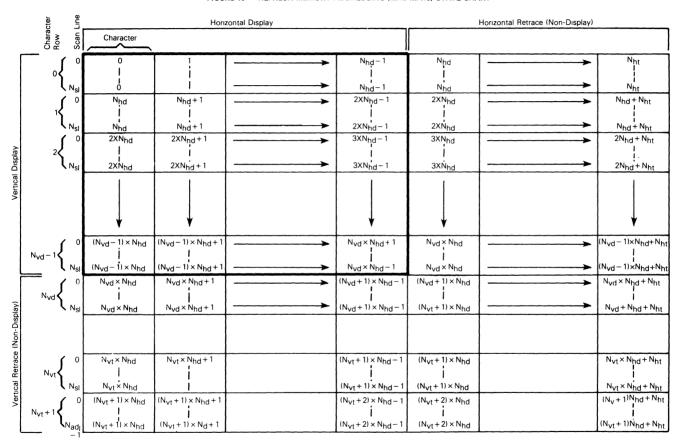
*Timing is shown for non-interlace and interlace sync modes Example shown has cursor programmed as Cursor Register = N_{hd} + 2 Cursor Start = 1

Cursor End = 3

**The initial MA is determined by the contents of Start Address Register, R12/R13 Timing is shown for R12/R13=0

Note 1 Timing values are described in Table 8

FIGURE 18 - REFRESH MEMORY ADDRESSING (MA0-MA13) STATE CHART



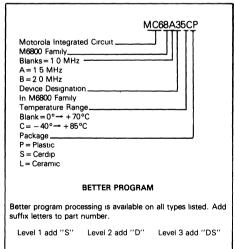
NOTE 1 The initial MA is determined by the contents of start address register, R12/R13 Timing is shown for R12/R13=0 Only Non-Interlace and Interlace Sync Modes are shown

FIGURE 19 - ROM PROGRAM WORKSHEET

The value in each register of the MC6845 should be entered without any modifications. Motorola will take care of translating into the appropriate format.

| ☐ All numbers a | ire in decimal | ☐ All numbers a | re in hex. |
|-----------------|-----------------------------|-------------------------------------|------------|
| | ROM Program Zero (PROG = 0) | ROM Program One (PROG = 1) | |
| RO | | | |
| R1 | | | - |
| R2 | | | - |
| R3 | | | |
| R4 | | | |
| R5 | | | |
| R6 | | | |
| R7 | | | - |
| R8 | | | |
| R9 | | | į |
| R10 | | _ | |
| R11 | | | |

ORDERING INFORMATION



| Level 1 add "S" | Level 2 add "D" | Level 3 add "D |
|------------------|---------------------|----------------|
| H _i T | emp Cycles — (-2 | nax |
| | Hour Burn-in at 125 | - |
| | | |

| Speed | Device | Temperature Range |
|---------|---------------------------------|----------------------------|
| 1 0 MHz | MC6835P,L,S MC6835CP,CL,CS | 0 to 70°C -40 to +85°C |
| 1 5 MHz | MC68A35P,L,S MC68A35CP,CL,CS | 0 to +70°C -40 to +85°C |
| 2 0 MHz | MC68B35P,L,S | 0 to +70°C |



MC68A39 (1.5 MHz) MC68B39 (2.0 MHz)

Advance Information

FLOATING-POINT ROM

The MC6839 standard product ROM provides floating point capability for the MC6809 or MC6809E MPU. The MC6839 implements the entire IEEE Proposed Standard for Binary Floating Point Arithmetic Draft 8.0, providing a simple, economical and reliable solution to a wide variety of numerical applications. The single- and double-precision formats provide results which are bit-for-bit reproducible across all Draft 6.0 implementations, while the extended format provides the extra precision needed for the intermediate results of long calculations, in particular the implementation of transcendental functions and interest calculations. All applications benefit from extensive error-checking and well-defined responses to exceptions, which are strengths of the IEEE proposed standard.

The MC6839 takes full advantage of the advanced architectural features of the MC6809 microprocessor. It is position-independent and re-entrant, facilitating its use in real-time, multi-tasking systems

- Totally Position Independent
 - Operates in any Contiguous 8K Block of Memory
- Re-Entrant
 - No Use of Absolute RAM
 - All Memory References are made Relative to the Stack Pointer
- Flexible User Interface
 - Operands are Passed to the Package by One of Two Methods
 Machine Registers are used as Pointers to the Operands
 The Operands are Pushed onto the Hardware Stack
 - The Latter Method Facilitates the use of the MC6839 in High-Level Language Implementations
- Easy to Use Two/Three Address Architecture
 - The User Specifies Addresses of Operands and Result and Need Not be Concerned with any Internal Registers or Intermediate Results
- A Complete Implementation of the Proposed IEEE Standard Draft 6.0
 - Includes All Precisions, Modes, and Operations Required or Suggested by the Standard
 - · Single, Double, and Extended Formats
 - Includes the Following Operations

Add

Subtract

Multiply

Divide

Remainder

Square Root

Integer Part Absolute Value

Negate

Predicate Compares

Condition Code Compares

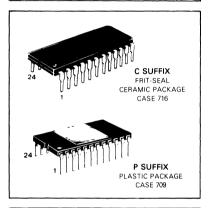
Convert Integer + Floating Point

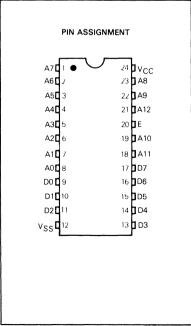
Convert Binary Floating Point → Decimal String

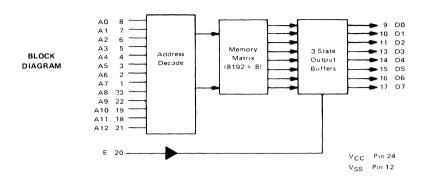
MOS

(N-CHANNEL, SILICON-GATE)

FLOATING-POINT READ-ONLY MEMORY







ABSOLUTE MAXIMUM RATINGS

| Rating | Symbol | Value | Unit |
|-----------------------------|------------------|---------------|------|
| Supply Voltage | Vcc | -05 to +70 | V |
| Input Voltage | V _{in} | -05 to +70 | V |
| Operating Temperature Range | TA | 0 to +70 | °C |
| Storage Temperature Range | T _{stg} | - 65 to + 150 | °C |

CAPACITANCE

(f = 1 0 MHz, T_{Δ} = 25°C, periodically sampled rather than 100% tested)

| Characteristic | Symbol | Max | Unit |
|--------------------|------------------|-----|------|
| Input Capacitance | C _{in} | 8 | pF |
| Output Capacitance | C _{out} | 15 | pF |

This device contains circuitry to protect the inputs against damage due to high static voltages or electric fields, however, it is advised that normal precautions be taken to avoid application of any voltage higher than maximum rated voltages to this high impedance circuit. Reliability of operation is enhanced if unused inputs are tied to an appropriate logic voltage (e.g., either VSS or VCC).

DC OPERATING CONDITIONS AND CHARACTERISTICS

(Full operating voltage and temperature range unless otherwise noted)

RECOMMENDED DC OPERATING CONDITIONS

| Parameter | Symbol | Mın | Nom | Max | Unit |
|--|--------|-----|-----|-----|------|
| Supply Voltage (VCC must be applied at least 100 μs before proper device operation is achieved) | Vcc | 45 | 50 | 55 | ٧ |
| Input High Voltage | VIH | 20 | - | 5.5 | V |
| Input Low Voltage | VIL | -05 | - | 0.8 | V |

DC CHARACTERISTICS

| Characteristic | S | mbol | Min | Тур | Max | Unit |
|---|---|-------|------|-----|-----|------|
| Input Current (V _{IN} = 0 to 5 5 V) | | lin | - 10 | _ | 10 | μΑ |
| Output High Voltage ($I_{OH} = -220 \mu A$) | 1 | ∕он ∣ | 24 | - | _ | ٧ |
| Output Low Voltage (I _{OL} = 3 2 mA) | 1 | VOL | - | - | 0 4 | ٧ |
| Output Leakage Current (Three-State) (E = 2 0 V, Vout = 0 V to 5 5 V) | | lLO | - 10 | - | 10 | μΑ |
| Supply Current - Active* (Minimum Cycle Rate) | | lcc | - | 25 | 40 | mΑ |
| Supply Current — Standby (E = V _{IH}) | | ISB | - | 7 | 10 | mΑ |

^{*}Current is proportional to cycle rate

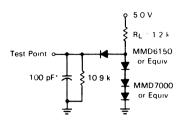
AC OPERATING CONDITIONS AND CHARACTERISTICS

(Read Cycle)

RECOMMENDED AC OPERATING CONDITIONS ($T_A = 0$ to 70°C, $V_{CC} = 5.0 \text{ V} \pm 10\%$ All timing with $t_r = t_f = 20 \text{ ns}$, load of Figure 1)

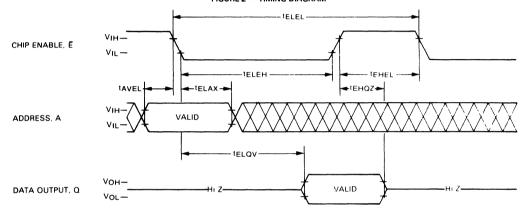
| Parameter | Symbol | MC6 | 8A39 | MC6 | Unit | |
|---|-------------------|-----|------|-----|------|------|
| rarameter | Symbol | Mın | Max | Min | Max | Unit |
| Chip Enable Low to Chip Enable Low of Next Cycle (Cycle Time) | †ELEL | 450 | _ | 375 | _ | ns |
| Chip Enable Low to Chip Enable High | †ELEH | 300 | - | 250 | _ | ns |
| Chip Enable Low to Output Valid (Access) | †ELQV | - | 300 | _ | 250 | ns |
| Chip Enable High to Output High Z (Off Time) | tEHQZ | - | 75 | - | 60 | ns |
| Chip Enable Low to Address Don't Care (Hold) | t _{ELAX} | 75 | - | 60 | - | ns |
| Address Valid to Chip Enable Low (Address Setup) | †AVEL | 0 | - | 0 | _ | ns |
| Chip Enable Precharge Time | tehel. | 110 | - | 70 | - | ns |

FIGURE 1 - AC TEST LOAD



*Includes Jig Capacitance

FIGURE 2 - TIMING DIAGRAM



INTRODUCTION

Since the earliest days of computers it has has been obvious that no computer was capable of doing all desirable mathematical operations in binary integer arithmetic. To meet the needs of those applications requiring the manipulation of real numbers, floating point (FP) evolved and became widely used. Unfortunately, each computer manufacturer created his own floating point (FP) representation and the ensuing wide variation in formats, accuracy, and exception handling almost guarantees that a program executed on one computer will get different results if executed on another computer.

Meanwhile, research has been completed which formulates an optional binary floating point representation. Unfortunately, the existing manufacturers have far too much money invested in software and hardware to incur the costs of conversion to a new standard. Powerful microprocessors, on the other hand, were in their infancy and the floating point experts saw the opportunity to standardize a floating point format for microprocessors. The IEEE appointed a committee to address the standard and their work resulted in the IEEE Proposed Standard for Binary Floating Point Arithmetic Draft 8.0

The MC6839 represents a complete implementation of the IEEE proposed standard. Since hardware implementations of floating point (FP) are always several orders of magnitude faster (and more expensive) than software implementations, the MC6839 substitutes increased functionality for speed. Therefore, the MC6839 supports all precisions, modes, and

operations required or suggested by the IEEE proposed standard

From its very inception, the M6809 microprocessor was designed to support a concept of ROMable software by an improved instruction set and addressing modes. It was felt that the only way to reduce the escalating cost of software was for the silicon manufacturer to supply software on silicon. Since the manufacturer can amortize the cost of developing the software over a very large volume, the cost of this software, above normal masked ROM costs, will be low Also, to be useful in many diverse systems, the ROM must be position-independent and re-entrant.

The intent of this Advance Information (data) Sheet is to provide the reader with enough information to make an intelligent decision as to whether the MC6839 is applicable to his system. The intent is not to provide all the details necessary to interface or program the MC6839, a users manual is available for that purpose. A familiarity with the MC6809 instruction set is assumed in this document.

PHYSICAL CHARACTERISTICS

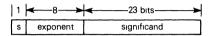
The MC6839 is housed in one 24-pin 8K-by-8 mask programmable ROM the MCM68364 This ROM uses a single 5 V power supply and is available with access times of 250 or 350 ns. The MC6839 is designed to be used in MC6809 or MC6809E systems with up to 2 MHz internal clocks. Full device characteristics can be found at the front of this data sheet.

FLOATING POINT FORMATS

The MC6839 supports the three precisions suggested by the IEEE Proposed Floating Point Standard. single, double, and extended. The values occupy 32, 64, and 80 bits (4, 8, and 10 bytes) respectively in the users memory. The formats of the three precisions are described in the following paragraphs.

SINGLE FORMAT

All single precision numbers are represented in four bytes as



The exponent is biased by +127. That is exponent of $.2^0$ is 127, $.2^2$ is 129, and 2^{-2} is 125. The significand is stored in sign magnitude rather than twos complement form. The equation for the single form representation is

 $x = (-1)s \times 2(exp - 127) \times (1 \text{ significand})$

s = sign of the significand

exp = biased exponent

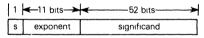
significand = bit string of length 23 encoding the significant bits of the number that follow the binary point, yielding a 24-bit significant digit field for the number that always begins "1______"

Examples:

+1.0= 1.0 × 20 = \$3F 80 00 00 +3 0 = 1.5 × 21 = \$40 40 00 00 -1 0 = -1.0 × 20 = \$BF 80 00 00

DOUBLE FORMAT

All double precision numbers are represented by an 8-byte string as



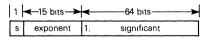
For double formats the exponent is biased by + 1023 The rest of the interpretation is the same as for single format. The equation for double format is

 $x = (-1)s \times 2(exp - 1023) \times (1 \text{ significand})$

Examples:

EXTENDED FORMAT

Single- and double-formats should be used to represent the bulk of floating point (FP) numbers in the user's system (e.g., storage of arrays). Extended should only be used for intermediate calculations such as occur in the evaluation of a complex expression. In fact, extended may not be used at all by most users, but since it is required internally, it is optionally provided. Extended numbers are represented in 10 bytes as



A notable difference between this format and single and double is the 1.0 is explicitly present in the significand and the exponent contains no bias and is in twos complement form. The equation for double extended is

 $x = (-1)s \times 2exp \times significand$

where the significand contains the explicit 1 0.

Examples:

| $0.5 = 1.0 \times 2^{-}$ | | | | | | | | | | | |
|--------------------------------|---|------|----|----|----|----|----|----|----|----|----|
| $-1.0 = -1.0 \times 2^{\circ}$ | = | \$80 | 00 | 80 | 00 | 00 | 00 | 00 | 00 | 00 | 00 |
| $384.0 = 1.5 \times 2^{8}$ | = | \$00 | 08 | CO | 00 | 00 | 00 | 00 | 00 | 00 | 00 |

BCD STRINGS

A BCD string is the input to the BCD-to-Floating-Point conversion operation and the output of the Floating-Point-to-BCD conversion operation. All BCD strings have the following format:

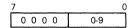
| 0 | 1 | 5 | | 25 | |
|----|----------------------|----|-----------------------|----|---|
| se | 4 digit BCD exponent | sf | 19 digit BCD fraction | р | l |

se = sign of the exponent \$00 = plus, \$0F = minus (one byte)

sf = sign of the fraction. \$00 = plus, \$0F = minus. (one byte)

p = number of fraction digits to the right of the decimal point (one byte)

All BCD digits are unpacked and right justified in each byte.



The byte ordering of the fraction and exponent is consistent with all Motorola processors in that the most-significant BCD digit is in the lowest memory address.

Examples:

| LAUIT | ipics. | | | | | | |
|-------|-------------------------|---------|------|----|----|----|--------------------|
| 2.0 | $0 = 2.0 \times 10^{0}$ | (p = 0) | | | | | |
| | Address | Data | | | | | |
| | 0000 | 00 | | | | | $\{se = +\}$ |
| | 0001 | 00 | 00 | 00 | 00 | | {exponent = 0} |
| | 0005 | 00 | | | | | $\{sf = +\}$ |
| | 0006 | 00 | 00 | 00 | 00 | 00 | {fraction = 2} |
| | 000B | 00 | 00 | 00 | 00 | 00 | |
| | 0010 | 00 | 00 | 00 | 00 | 00 | |
| | 0015 | 00 | 00 | 00 | 02 | | |
| | 0019 | 00 | | | | | $\{p = 0\}$ |
| or 2. | 0 = 20,000 × | 10-4(p | = 0) | | | | |
| | Address | Data | | | | | |
| | 0000 | 0F | | | | | $\{se=-\}$ |
| | 0001 | 00 | 00 | 00 | 04 | | {exponent = 4} |
| | 0005 | 00 | | | | | $\{sf = +\}$ |
| | 0006 | 00 | 00 | 00 | 00 | 00 | {fraction = 20000} |
| | 000B | 00 | 00 | 00 | 00 | 00 | |
| | 0010 | 00 | 00 | 00 | 00 | 02 | |
| | 0015 | 00 | 00 | 00 | 00 | | |
| | 0019 | 00 | | | | | $\{p = 0\}$ |
| | | | | | | | |

(The above might be the output of a Floating-Point-to-BCD with k=5)

or $2.0 = 2.0 \times 10^{\circ} (p = 10)$

| Address | Data | | | | | |
|---------|------|----|----|----|----|-------------------------------|
| 0000 | 00 | | | | | $\{se=+\}$ |
| 0001 | 00 | 00 | 00 | 00 | | (exponent = 0) |
| 0005 | 00 | | | | | $\{sf = +\}$ |
| 0006 | 00 | 00 | 00 | 00 | 00 | $\{fraction = 200000000000\}$ |
| 000B | 00 | 00 | 00 | 02 | 00 | |
| 0010 | 00 | 00 | 00 | 00 | 00 | |
| 0015 | 00 | 00 | 00 | 00 | | |
| 0019 | 0A | | | | | $\{p = 10\}$ |

INTEGERS

Two sizes of integers are supported; short and double. Short integers are 16 bits long and double integers are 32 bits long. The byte ordering is consistent with all Motorola processors in that the most-significant bits are in the lowest address.

SPECIAL VALUES

No derivable floating point format can represent the infinite number of possible real numbers, so it is very useful if some special numbers are recognized by a floating point package. These numbers are +0,-0,+ infinity, - infinity, very small (almost zero) numbers, and in some cases unnormalized numbers. Also, it is convenient to have a sepcial format which indicates that the contents of memory do not contain a valid floating point number. This "not a number" might occur if a variable is defined in a HLL and is used before it is initialized with a value. The most positive and negative exponents of each format are reserved to represent these special values.

The detailed description of these special values is given in a later section.

ARCHITECTURE

All floating point operations are of the "two address" or "three address" variety, all the user need supply are the addresses of the operand(s) and the result The package looks for operands at the specified location(s) and delivers the result to the specified destination. For example,

Intermediate results are never presented to the user, therefore, there are no internal "registers" to be concerned about, keeping the interface as simple as possible. The end result is ease of use

There is a user defined floating point control block (fpcb) that defines the mode of the package. This control block is much like the control blocks frequently used to define I/O or operating system operations. The fpcb is discussed in detail in a later section.

SUPPORTED OPERATIONS

The MC6839 supports the following operations. On any particular call to the floating point ROM a 1-byte opcode which immediately follows the LBSR instruction chooses the desired operation. Below are short descriptions of the functions implemented in the MC6839 along with suggested menmonics. A table containing the opcodes and calling sequences for these functions is presented at the end of this data sheet.

| ASCII Mnemonie | C Description |
|-------------------|---|
| FADD | Add arg1 to arg2 and store the result |
| FSUB | Subtract arg2 from arg1 and store the result |
| FMUL | Multiply arg1 times arg2 and store the result |
| FDIV | Divide arg1 by arg2 and store the result |
| FREM | Take the remainder of arg1 divided by arg2 and store the result. The remainder is biased to lie in the range − arg2/2 < remainder < + arg2/2, instead of the usual range of 0≤ remainder < arg2. This bias makes the function more useful in the implementation of trigonometric and other functions. |
| FCMP | Compare arg1 with arg2 and set the condition codes to the result of the compare Arg1 and arg2 can be of different precisions |
| FTCMP | Compare arg1 with arg2 and set the condition codes to the result of the compare. In addition, trap if an unordered exception occurs regardless of the state of the UNOR (unordered) bit in the trap enable byte of the fpcb |
| FPCMP | A predicate compare, this means compare $arg1$ with $arg2$ and affirm or disaffirm the input predicate (e.g., 'is $arg1 = arg2'$ or 'is $arg1 < arg2'$) |
| FTPCMP | A trapping predicate compare, same as the predicate compare except trap on an unordered exception regardless of the state of the UNOR (unordered) bit in the trap enable byte of the fpcb |
| FSQRT | Returns the square root of arg2 in the result |
| FINT | Returns the interger part of arg2 in the result. The result is still a floating point number. For example, the integer part of 3 14159 is 300000 |
| FFIXS | Convert arg2 to a short (16-bit) binary integer |
| FFIXD | Convert arg2 to a long (32-bit) binary integer |
| FFLTS | Convert a short binary integer to a floating point result |
| FFLTD | Convert a long binary integer to a floating point result |
| BINDEC | Convert a binary floating point value to a BCD decime string. |
| DECBIN | Convert a BCD decimal string to a binary floating point result |
| FABS | Return the absolute value of arg2 in the result |
| FNEG | Return the negative of arg2 in the result |
| FMOV | Move (or convert) arg1 — arg2. This function is useful for changing precisions (e.g., single to double) with full exception checking for possible overflow or underflow. |
| All rous | tines except EMOV and the compares accept |

All routines, except FMOV and the compares, accept arguments of the same precision and generate a result with the same precision. For moves and compares the sizes of the arguments are passed to the package in a parameter word.

Details of each operation can be found in the MC6839 Users Manual

MODES OF OPERATION

In addition to supporting a wide range of precisions and operations, the MC6839 supports all modes required or suggested by the IEEE Proposed Floating Point Standard. These include rounding modes, infinity closure modes, and exception handling modes. The various modes are selected by bits in the floating point control block (fpcb) that resides in user memory. Thus, each user or task can have a unique set of modes in effect for his calculations. The selection bits are defined in a later section on the fpcb

ROUNDING MODES

Four rounding modes are suggested by the IEEE Proposed Floating Point Standard. They are

| Round to nearest | (RN) |
|-------------------------------|------|
| 2. Round toward zero | (RZ) |
| 3. Round toward plus infinity | (RP) |
| 4 Round toward minus infinity | (RN) |

Round nearest will be used by most users because it provides the most accurate answers for most calculations Round towards zero (truncate) is useful when the MC6839 implements real numbers in some high level languages that require truncation (i.e., FORTRAN). Round towards plus and minus infinity are used in interval arithmetic.

Normally a result is rounded to the precision of its destination. However, when the destination is Extended, the user can specify that the result significand be rounded to the precision of the basic format — single, double, or extended — of his choice, although the exponent range remains extended

NO DOUBLE ROUNDING — The MC6839 is implemented such that no result will undergo more than one rounding error

INFINITY CLOSURE MODES

The way in which infinity is handled in a floating point package may limit the number of applications in which the package can be used. To solve this problem, the proposed IEEE standard requires two types of infinity closures. A bit in the control byte of the Floating Point Control Block (fpcb) will select the type of closure that is in effect at any time.

AFFINE CLOSURE - In affine closure

minus infinity < {every finite number} < plus infinity
Thus, infinity takes part in the real number system in the
same manner as any other signed quantity

PROJECTIVE CLOSURE - In projective closure

infinity = minus infinity = plus infinity

and all comparisons between infinity and a floating point number involving order relations other than equal (=) or not equal (\neq) are invalid operations. In projective closure the real number system can be thought of as a circle with zero at the top and infinity at the bottom

NORMALIZE MODE

The purpose of the normalize mode is to prevent unnormalized results from being generated, which can otherwise happen. Such an unnormalized result arises when a denor-

malized operand is operated on such that its fraction remains not normalized but its exponent is no longer at its original minimum value. By transforming denormalized operands to normalized, internal form upon entering each operation, unnormalized results are guaranteed not to occur

Thus, when operating in this mode the user can be assured that no attempt will be made to return an unnormalized value to a single or double destination. A bit in the control byte of the fpcb selects whether or not this mode is in effect. This mode is forced whenever the round mode is either round toward plus or minus infinity. Unnormalized numbers entering an operation are not affected by this mode, only denormalized ones are. Unnormalized and denormalized operands are discussed in a later section.

EXCEPTIONS

One of the greatest strengths of the IEEE Proposed Floating Point Standard is the regular and consistant handling of exceptions. Existing floating point implementations are quite varied in the way they handle exceptions, so the proposed IEEE standard has very carefully prescribed how exceptions must be handled and what constitutes an exception Seven types of exceptions will be recognized by the MC6839. Only the first 5 are required by the proposed IEEE standard. They are:

- 1 Invalid Operation a general exception that arises when an operation has gone so wrong that the program cannot return any reasonable result or fit the exception into any of the other more specific classes
- 2 Underflow arises when an operation generates a result that is too small to fit into the desired result precision
- 3 Overflow arises when an operation generates a result that is too large to fit into the desired result precision
- 4 Division by Zero arises when division by zero is attempted
- 5 Inexact Result arises when the result of an operation was not exact and therefore was rounded to the desired precision before being returned to the user
- 6 Integer Overflow arises when the binary integer result of a FIXS(D) operation cannot fit into 16(32) bits
- 7 Comparison of Unordered Values arises when one of the arguments to a compare operation is a "NAN" or an infinity in the projective closure mode (See the Infinity and Not a Number paragraphs for further explanation of NANs and infinity)

For each exception the caller will be given the option of specifying whether the package should. (1) trap to a user supplied trap routine to process the exception, or (2) deliver a default result specified by the proposed standard and proceed with execution. For most users the default result is adequate and the user need not write any trap handlers. Regardless of whether a trap is specified or not, a status bit will be set in the status byte of the fpcb and will remain set until cleared by the caller's program. Selection of whether to trap or to continue will be made by setting bits in the trap enable byte of the fpcb. For more details on the fpcb see the section on the Floating Point Control Block (fpcb)

If a trap is taken, the floating point package supplies a pointer that points to an area on the stack containing the following diagnostic information:

- 1. Event that caused the trap (overflow, etc.)
- 2. Where in the caller's program
- 3. Opcode
- 4. The input operands
- 5. The default result in internal format

In the event more than one exception occurs during the same operation, only one trap is invoked according to the following precedence.

- 1 Invalid Operation
- 2. Overflow

- 3 Underflow
- 4. Division by Zero
- 5. Unordered
- 6. Integer Overflow
- 7. Inexact Result

The user supplied trap routine (if any) will usually do 1 of 3 things:

- 1. Fix the result
- 2. Do nothing to the result and allow the floating point package to deliver the default value to the result
- 3. Abort execution

Sufficient detils on how to write a trap routine are furnished in the MC6839 Users Manual

USER INTERFACE

There are two types of calls to the floating point package, register calls and stack calls. For register calls the user loads the machine registers with pointers (addresses) to the operand(s) and to the result, the call to the package is then performed. For stack calls the operand(s) is pushed on the stack and the call to the package is performed with the result replacing the operands on the stack after completion. The operand(s) must be pushed least-significant bytes first; this is consistent with the other Motorola architectures in that the most-significant byte resides in the lowest address. The two types of calls look like.

General form of a register call:

load registers

LBSR fpreg register call

FCB opcode

Example of a position-independent call to the add routine

LEAU arg1, pcr

LEAY arg2, pcr

LEAX fpcbptr, pcr pointer to fpcb

TFR x, d LEAX result, pcr LBSR fprea

LBSR fpreg FCB fadd

General form of a stack call.

push arguments

LBSR fpstak stack call

FCB opcode

pull result

Example of a stack call to the add routine.

push argument 1

push argument 2

push fpcbptr pointer to fpcb

LBSR fpstak FCB fadd pull result

Details of the calling sequence for every type of operation can be found in the MC6839 Users Manual; a reference table of calling sequences and opcodes can be found at the end of this data sheet

STACK REQUIREMENTS

When the MC6839 is called by the user, the package reserves local storage on the hardware stack. It then moves the input arguments from user memory to the local storage area and expands them into a convenient internal format. The operations use these "internal" numbers to arrive at an "internal" result which is then converted to the memory format of the result and returned to the user. For this reason, the user must insure that adequate memory exists on the hardware stack before calling the MC6839. The maximum stack sizes that any particular function will ever find necessary are

register calls 150 bytes stack calls 185 bytes

FLOATING POINT CONTROL BLOCK (fpcb)

The fpcb is a user-defined block that contains information needed by the floating point package. The fpcb is also used to pass status back to the caller or to invoke the trap routine. The fpcb must reside in the user RAM space to insure that the package can remain re-entrant. The caller of the floating point package must pass the address of the fpcb on each call. The format of the fpcb is

| control byte | 0 | | | | |
|-------------------------|---|--|--|--|--|
| trap enable byte | | | | | |
| status byte | 2 | | | | |
| secondary status byte | 3 | | | | |
| address of trap routine | 4 | | | | |
| address of trap routine | 5 | | | | |

The meaning of the various bit fields within the fpcb are discussed in detail in the following paragraphs

CONTROL BYTE — The control byte configures the floating point package for the caller's operation and is written by the user Various fields in the byte set the precision, round, infinity closure, and normalize modes

| 7 | 6 | 5 | 4 | 3 | 2 | 11 | 0 |
|---|-----------|---|---|-----|-------|------|-----|
| | Precision | | x | NRM | Round | Mode | A/P |

Bit 0 Closure (A/P) Bit

0 = projective closure

1 = affine closure

Bits 1-2 Round Mode

00 = round to nearest (RN)

01 = round to zero (RZ)

10 = round to plus infinity (RP)

11 = round to minus infinity (RM)

Bit 3 Normalize (NRM) Bit

1= normalized denormalized numbers while in internal format before using Precludes the creation of unnormalized numbers

0 = do not normalize denormalized numbers (warning mode)

NOTE

If the rounding mode is RM or RP then normalize mode is forced. Unnormalized numbers are not affected by bit 3

Bit 4 Undefined, reserved

Bits 5-7 Precision Mode

000 = Single

001 = Double

010 = Extended with no forced rounding of result

011 = Extended - force round result to single

100 = Extended - force round result to double

101 = Undefined, reserved

110 = Undefined, reserved

111 = Undefined, reserved

Note that if the control byte is set to zero by the user, all defaults in the IEEE Proposed Floating Point Standard will be selected

STATUS BYTE

| 7 | 6 | 5 | 4 | 3 | 2 | 11 | 0 |
|---|-----|-----|----|----|-----|-----|-----|
| × | INX | IOV | UN | DZ | UNF | OVF | IOP |

The bits in the status byte are set if any errors have occurred. Each bit of the status byte is a "sticky" bit in that it must be manually reset by the user. The FP package writes bits into the status byte but never clears existing bits. This is done so that a long calculation can be completed and the status need only be checked once at the end.

Bit 0 Invalid opertion (see secondary status)

Bit 1 Overflow

Bit 2 Underflow

Bit 3 Division by zero

Bit 4 Unordered

Bit 5 Integer overflow

Bit 6 Inexact result

Bit 7 Undefined, reserved

TRAP ENABLE BYTE

| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---|-----|-----|------|----|-----|-----|-----|
| х | INX | IOV | UNOR | DZ | UNF | OVF | IOP |

A "1" in any bit of the trap enable byte enables the FP package to trap if that error occurs. The bit definitions are the same as for the status byte. Note that if a trapping compare is executed and the result is unordered, then the unordered trap will be taken regardless of the state of the UNOR bit in the trap enable byte.

SECONDARY STATUS (SS)

| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---|-------|---|---|---------|----------|--------|---|
| × | × | х | | Invalid | Operatio | n Type | |

The FP package will write a status into this byte any time a new IOP occurs. As is the case with the status bytes, it is up to the caller to reset the "IOP type" field

Bits 0-4 Invalid Operation Type Field

0= no IOP error

1 = square root of a negative number, infinity in projective mode, or a not normalized number

2= (+ infinity) + (- infinity) in affine mode

3= tried to convert NAN to binary integer

4 = in division 0/0, infinity/infinity or divisor is not normalized and the dividend is not zero and is finite

5 = one of the input arguments was a trapping NAN

6= unordered values compared via predicate other than = or +

7 = k out of range for BINDEC or p out of range for DECBIN

8 = projective closure use of + / - infinity

 $9 = 0 \times infinity$

10= in REM arg2 is zero or not normalized or arg1 is infinite

11 = unused, reserved

12 = unused, reserved

13 = BINDEC integer too big to convert

14 = DECBIN cannot represent input string

15 = tried to MOV a single denormalized number to a double destination

16= tried to return an unnormalized number to single or double (invalid result)

17 = division by zero with divide by zero trap disabled

TRAP VECTOR — If any of the traps occur, the FP package will *jump* indirectly through the trap address in the fpcb with an index in the A accumulator indicating the trap type:

0 = Invalid Operation

1 = Overflow

2 = Underflow

4= Unnormalized

5= Integer Overflow

6= Inexact Result

If more than 1 enabled trap occurs, the MC6839 will return the index of the highest priority enabled error. Index = 0 = invalid operation is the highest priority, and, index = 6 is the lowest

SPECIAL VALUES (SINGLE- AND DOUBLE-FORMAT)

The encoding of the special values are given below. Generally, when used as operands, the special values flow through an operation creating a predictable result. Note that as with normalized numbers the extended format differs slightly from the single- and double-formats.

ZERO

Zero is represented by a number with both a zero exponent and a zero significand. The sign is significant and differentiates between plus or minus zero.

| s | 0 | 0 |
|---|---|---|
| | | |

INFINITY

The infinities are represented by a number with the maximum exponent and a zero significand. The sign differentiates plus or minus infinity.

| ١ | | | | |
|---|---|------|------|---|
| | s | 1111 | 1111 | 0 |
| | | | | |

DENORMALIZED (SMALL NUMBERS)

When a number is so small that its exponent is the smallest allowable normal biased value (1), and it is impossible to normalize the number without further decrementing the exponent, then the number will be allowed to become denormalized. The format for denormalized numbers has a zero exponent and a non-zero significand. Note that in this form the implicit bit is no longer 1 but is zero. The interpretation for denormalized numbers is

Single: $X = (-1)s \times 2 - 126 \times (0 \text{ significand})$ Double: $X = (-1)s \times 2 - 1022 \times (0 \text{ significand})$

Note that the exponent is always interpreted as 2-126 for single and 2-1022 for double instead of 2-127 and 2-1023 as might be expected. This is necessary since the only way to insure the implicit bit becomes zero is to right shift the significand (divide by 2) and increment the exponent (multiply by 2). Thus, the exponent ends up with the interpretation of 2-126 or 2-1022.

The format for denormalized numbers is

| _ | | |
|---|---|----------|
| s | 0 | non-zero |
| | | |

Note that zero may be considered a special case of denormalized numbers where the number is so small that the significand has been reduced to zero.

Examples:

Single:

 $1.0 \times 2^{-128} = 0.25 \times 2^{-126} = $00 \ 20 \ 00$

Double.

 $1.0 \times 2 - 1025 = 0.125 \times 2 - 1022 = $00 02 00 00 00 00 00$

NOT A NUMBER (NAN)

A number containing a NAN indicates that the number is not a valid floating number. NANs can be used to initialize areas in memory to indicate they have not had a valid floating point number stored in them. They are also created by the MC6839 to indicate that an operation could not return a valid result.

The format for a NAN has the largest allowable exponent, a non-zero significand, and an undefined sign. As an implementation feature (not required by the IEEE Proposed Floating Point Standard), the non-zero fraction and undefined sign are further defined

| $\overline{}$ | | | | | |
|---------------|-----------|---|-------------------|----|------|
| d | 1111 1111 | t | operation address | 00 | 0000 |
| | | | | | |

- d. 0= This NAN has never entered into an operation with another NAN
 - 1= This NAN has entered into an operation with other NANs
- t: 0= This NAN will not necessarily cause an invalid operation trap when operated upon.
 - 1 = This NAN will cause an invalid operation trap when operated upon (trapping NAN)

Operation address:

The 16 bits, immediately to the right of the t bit, contain the address of the instruction immediately following the call to the FP package of the operation that caused the NAN to be created. If d (double NAN) is also set, the address is arbitrarily one of the addresses in the two or more offending NANs.

SPECIAL VALUES (EXTENDED FORMAT)

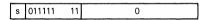
ZERO

Zero is represented by a number with the smallest unbiased exponent and a zero significand



INFINITY

Infinity has the maximum unbiased exponent and a zero significand



DENORMALIZED NUMBERS

Denormalized numbers have the smallest unbiased exponent and a non-zero significand

| ı | s | 100 | 000 | 0 | non-zero |
|---|---|-----|-----|---|----------|

The exponent of denormalized extended and internal numbers is interpreted as having the exponent value 1 greater than the smallest unbiased exponent value. Thus, a denormalized number has the exponent -16384, but has the value

$$(-1)s \times 2 - 16383 \times 0.f$$

Example:

 $1.0 \times 2 - 16387 = 0625 \times 2 - 16383 = $40 00 08 00 00 00 00 00 00$

NANs

NANs have the largest unbiased exponent and a non-zero significand. The operation addresses "t" and "d" are implementation features and are the same as for single- and double-formats.

| п | | | | | | | |
|---|---|-------|------|---|---|----------------|----------|
| 1 | d | 011 . | 1111 | 0 | t | operation addr | 00000000 |

The operation address always appears in the 16 bits immediately to the right of the t bit

UNNORMALZIED NUMBERS

Unnormalized numbers occur only in extended or internal format. Unnormalized numbers have an exponent greater than the minimum in the extended format (i.e., they are not denormalized or normal zero) but the explicit leading bit is a zero. If the significand is zero, this is an unnormalized zero. Even though unnormalized numbers and denormalized numbers are handled similarly in most cases, they should not be confused. Denormalized numbers are numbers that are very small — have minimum exponent — and hence have lost some bits of significance. Unnormalized numbers are not necessarily small (the exponent may be large or small) but the significand has lost some bits of significance, hence, the explicit bit and possibly some of the bits to the right of the explicit bit are zero.

| s | >100000 | 0. | significand |
|---|---------|----|-------------|

Note that unnormalized numbers cannot be represented — and hence cannot exist — for single- and double-formats. Unnormalized numbers can only be created when denormalized numbers in single- or double-format are represented in extended or internal formats.

Example:

 $.0625 \times 2^{2}$ (unnorm.) = \$00 02 08 00 00 00 00 00 00 00

MC6839 CALLING SEQUENCE AND OPCODE REFERENCE TABLE

| Function | Opcode | Register Calling Sequence | Stack Calling Sequence1 |
|--|--|---|--|
| FADD FSUB FMUL FDIV FREM FSQRT FINT FFIXS FFIXD FAB | \$00 \$02 \$04 \$06 \$08 \$12 \$14 \$16 \$18 \$1E | Register Calling Sequence U — Addr of Argument #1 Y — Addr of Argument #2 D — Addr of FPCB X — Addr of Result LBSR FPREQ FCB < opcode> Y — Addr of Argument D — Addr of FPCB X — Addr of FPCB X — Addr of FPCB X — Addr of FPCB X — Addr of Result LBSR FPREG FCB < opcode> | Stack Calling Sequence! Push Argument #1 Push Argument #2 Push Addr of FPCB LBSR FPSTAK FCB < opcode > Pull Result Push Argument Push Addr of FPCB LBSR FPSTAK FCB < opcode > Pull Result |
| FNEG FFLTS FFLTD | \$20 \$24 \$26 | | |
| FCMP FTCMP FPCMP FTPCMP | \$8A \$CC \$8E \$D0 | U ← Addr of Argument #1 Y ← Addr of Argument #2 D ← Addr of FPCB X ← Parameter Word LBSR FPREG FCB < opcode> | Push Argument #1 Push Argument #2 Push Parameter Word Push Addr of FPCB LBSR FPSTAK FCB < opcode> Pull Result (if predicate compare) |
| | | NOTE Result returned in the CC register For predicate compares the Z-Bit is set if predicate is affirmed cleared if disaffirmed | NOTE Result returned in the CC register for regular compares. For predicate compares a one byte result is returned on the top of the stack. The result is zero if affirmed and — 1(\$FF) if disaffirmed. |
| FMOV | \$9A | U ← Precision Parameter Word Y ← Addr of Argument D ← Addr of FPCB X ← Addr of Result LBSR FPREG FCB < opcode> | Push Argument Push Precision Parameter Word Push Addr of FPCB LBSR FPSTAK FCB < opcode > Pull Result |
| BINDEC | \$1C | U ← k (# of digits in result) Y ← Addr of Argument D ← Addr of FPCB X ← Addr of Decimal Result LBSR FPREG FCB < opcode> | Push Argument Push k Push Addr of FPCB LBSR FPSTAK FCB < opcode > Pull BCD String |
| DECBIN | \$22 | U ← Addr of BCD Input String D ← Addr of FPCB X ← Addr of Binary Result LBSR FPREG FCB < opcode> | Push Addr of BCD Input String Push Addr of FPCB LBSR FPSTAK FCB < opcode> Pull Binary Result |

¹All arguments are pushed on the stack least-significant bytes first so that the high-order byte is always pushed last and resides in the lowest address

Entry points to the MC6839 are defined as follows FPREG = ROM start + \$3D FPSTAK = ROM start + \$3F

MC6839 EXECUTION TIMES Time in μs Using 2 MHz 6809

| Function | Single Precision | Double Precision | Extended Precision |
|--------------------------------|--------------------------------|--------------------------|--------------------------|
| FADD | 1200 – 3300 | 1500 - 3700 | 1100 – 3800 |
| • | t = 1200 + 40(A) + 50(N) | t = 1500 + 40(A) + 50(N) | t = 1100 + 40(A) + 50(N) |
| | where | | 1 |
| | A = # shifts to align operands | | 1 |
| | N=# shifts to normalize result | | 1 |
| FSUB | ADD + 11 | ADD + 11 | ADD + 11 |
| FMUL | 1400 – 1600 | 4100 – 4300 | 4600 - 4800 |
| FDIV | t = 2700 + 60(Q) | t = 5000 + 60(Q) | 5 = 6500 + 60(Q) |
| | where | | } |
| | Q=# of quotient bits which are | | 1 |
| | are a '1' | | |
| FABS | 540 | 750 | 650 |
| DECBIN | 8500 - 14,000 | 8500 - 23,000 | - |
| (time depends on magnitude | | | ł |
| of input) | 1 | | 1 |
| BINDEC | 35,000 - 48,000 | 67,000 - 85,000 | |
| (time depends on # significand | | | 1 |
| digits requested) | 1 | | ł. |



MC6840 (1.0 MHz) MC68A40 (1.5 MHz) MC68B40 (2.0 MHz)

PROGRAMMABLE TIMER MODULE (PTM)

The MC6840 is a programmable subsystem component of the M6800 family designed to provide variable system time intervals.

The MC6840 has three 16-bit binary counters, three corresponding control registers, and a status register. These counters are under software control and may be used to cause system interrupts and/or generate output signals. The MC6840 may be utilized for such tasks as frequency measurements, event counting, interval measuring, and similar tasks. The device may be used for square wave generation, gated delay signals, single pulses of controlled duration, and pulse width modulation as well as system interrupts.

- Operates from a Single 5 Volt Power Supply
- Fully TTL Compatible
- Single System Clock Required (Enable)
- Selectable Prescaler on Timer 3 Capable of 4 MHz for the MC6840, 6 MHz for the MC68A40 and 8 MHz for the MC68B40
- Programmable Interrupts (IRQ) Output to MPU
- Readable Down Counter Indicates Counts to Go Until Time-Out
- Selectable Gating for Frequency or Pulse-Width Comparison
- RESET Input
- Three Asynchronous External Clock and Gate/Trigger Inputs Internally Synchronized
- Three Maskable Outputs

MAXIMUM RATINGS

| Rating | Symbol | Value | Unit |
|---|------------------|------------------------|------|
| Supply Voltage | Vcc | -03 to +70 | V |
| Input Voltage | V _{in} | -0.3 to +7.0 | ٧ |
| Operating Temperature Range — T _L to T _h MC6840, MC68A40, MC68B40 MC6840C, MC68A40C | TA | 0 to +70 -40 to +85 | °C |
| Storage Temperature Range | T _{stg} | -55 to +150 | °C |

THERMAL CHARACTERISTICS

| Characteristic | Symbol | Value | Unit |
|--------------------|--------|-------|---------|
| Thermal Resistance | | | |
| Cerdip | ا ا | 65 | l∘c/w |
| Plastic | θJA | 115 | 1°C/ VV |
| Ceramic | | 60 | 1 |

This device contains circuitry to protect the inputs against damage due to high static voltages or electric fields, however, it is advised that normal precautions be taken to avoid application of any voltage higher than maximum rated voltages to this high-impedance circuit. Reliability of operation is enhanced if unused inputs are tied to an appropriate logic voltage level (e.g., either VSS or VCC).

MOS

(N-CHANNEL, SILICON-GATE DEPLETION LOAD)

PROGRAMMABLE TIMER

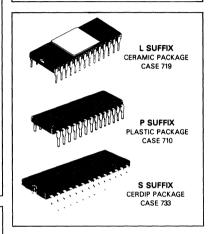
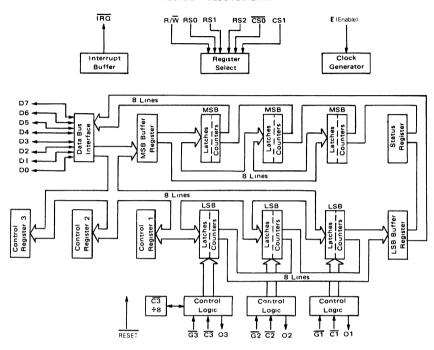


FIGURE 1 — PIN ASSIGNMENT

| _ | | | |
|---------------------|-----|----|-------------|
| ٧ss | 1 • | 28 | C1 |
| G2 🗖 | 2 | 27 | 01 |
| O2 [| 3 | 26 | G 1 |
| C2 t | 4 | 25 | D0 I |
| G 3 Д | 5 | 24 | D1 |
| 03 Д | 6 | 23 | D2 |
| сз Д | 7 | 22 | D 3 |
| RESET [| 8 | 21 | D D4 |
| IRQ [| 9 | 20 | D D5 |
| RSO [| 10 | 19 | D 6 |
| RS1 [| 11 | 18 | D 7 |
| RS2 | 12 | 17 | ΞE |
| R/W [| 13 | 16 | CS1 |
| v _{cc} t | 14 | 15 | cso |

FIGURE 2 - BLOCK DIAGRAM



POWER CONSIDERATIONS

The average chip-junction temperature, T_J, in °C can be obtained from

$$T_{J} = T_{A} + (P_{D} \bullet \theta_{JA})$$
Where. (1)

T_A ≡ Ambient Temperature, °C

 $\theta_{JA} \equiv Package Thermal Resistance, Junction-to-Ambient, °C/W$

 $P_D = P_{INT} + P_{PORT}$

 $PINT = ICC \times VCC$, Watts - Chip Internal Power

PPORT = Port Power Dissipation, Watts - User Determined

For most applications PPORT ◀PINT and can be neglected. PPORT may become significant if the device is configured to drive Darlington bases or sink LED loads

An approximate relationship between PD and TJ (if PPORT is neglected) is

$$P_D = K - (T_J + 273^{\circ}C)$$
 (2)

Solving equations 1 and 2 for K gives.

 $\text{ } \forall \text{ } P_{D} \bullet (T_{A} + 273^{\circ}\text{C}) + \theta_{JA} \bullet P_{D}^{2}$ (3

Where K is a constant pertaining to the particular part. K can be determined from equation 3 by measuring PD (at equilibrium) for a known TA. Using this value of K the values of PD and TJ can be obtained by solving equations (1) and (2) iteratively for any value of TA.

DC ELECTRICAL CHARACTERISTICS (V_{CC}=5 0 Vdc \pm 5%, V_{SS}=0, T_A=T_L to T_H unless otherwise noted)

| Characteristic | | Symbol | Min | Тур | Max | Unit |
|---|------------------------|------------------|--|-----|---------------------|------|
| Input High Voltage | | VIH | V _{SS} + 20 | _ | Vcc | ٧ |
| Input Low Voltage | | VIL | V _{SS} -03 | _ | V _{SS} +08 | ٧ |
| Input Leakage Current (V _{In} =0 to 5 25 V) | | I _{in} | _ | 10 | 2 5 | μΑ |
| Three-State (Off State) Input Current (V _{In} = 0 5 to 2 4 V) | D0-D7 | ^I TSI | _ | 20 | 10 | μА |
| Output High Voltage (I _{Load} = -205 µA) (I _{Load} = -200 µA) | D0-D7 Other Outputs | Vон | V _{SS} +24 V _{SS} +24 | - | <u>-</u> | V |
| Output Low Voltage (I _{Load} = 1 6 mA) (I _{Load} = 3 2 mA) | D0-D7 O1-O3, IRQ | VoL | _ | - | VSS+04 VSS+04 | ٧ |
| Output Leakage Current (Off State) (VOH = 2 4 V) | IRQ | lLOH | _ | 10 | 10 | μА |
| Internal Power Dissipation (Measured at T _A = T _L) | | PINT | _ | 470 | 700 | mW |
| Input Capacitance (V _{In} = 0, T _A = 25 °C, f = 1 0 MHz) | D0-D7 All Others | C _{In} | _ | - | 12 5 7 5 | pF |
| Output Capacitance $(V_{in} = 0, T_A = 25$ °C, f = 1 0 MHz) | IRQ 01, 02, 03 | C _{out} | _ | _ | 5 0 10 | pF |

AC OPERATING CHARACTERISTICS (See Figures 4-9)

| Characteristic | Symbol | MC6840 | | MC68A40 |) | MC68B40 |) | Unit |
|---|---|---------------|-------------------|---------------|--------------------|--|-------------------|----------------|
| Characteristic | Symbol | Min | Max | Min | Max | Min | Max | Unit |
| Input Rise and Fall Times (Figures 4 and 5) C, G and RESET | t _r , t _f | - | 1 0* | _ | 0 666* | _ | 0 500* | μS |
| Input Pulse Width Low (Figure 4) (Asynchronous Input) C, G and RESET | PWL | tcycE+tsu+thd | - | tcycE+tsu+thd | - | tcycE+tsu+thd | - | ns |
| Input Pulse Width High (Figure 5) (Asynchronous Input) C, G | PWH | tcycE+tsu+thd | | tcycE+tsu+thd | 1 | tcycE+t _{Su} +t _{hd} | | ns |
| Input Setup Time (Figure 6) (Synchronous Input) C, G and RESET | ^t su | 200 | - | 120 | - | 75 | - | ns |
| Input Hold Time (Figure 6) (Synchronous Input) C, G and RESET | ^t hd | 50 | - | 50 | - | 50 | - | ns |
| Input Synchronization Time (Figure 9) $\overline{C3}$ (-8 Prescaler Mode Only) | tsync | 250 | - | 200 | - | 175 | - | ns |
| Input Pulse Width C3 (-8 Prescaler Mode Only) | PW _L , PW _H | 120 | - | 80 | - | 60 | - | ns |
| Output Delay, O1-03 (Figure 7) (VOH = 2 4 V, Load B) TTL (VOH = 2 4 V, Load D) MOS (VOH = 0 7 VDD, Load D) CMOS | t _{co} t _{cm} t _{cmos} | - - - | 700 450 2 0 | _ _ _ | 460 450 1 35 | - - - | 340 340 1 0 | ns ns µs |
| Interrupt Release Time | t _{IR} | - | 12 | | 09 | _ | 07 | μS |

 t_r and $t_f \le t_{CYCE}$

MC6840 • MC68A40 • MC68B40

BUS TIMING CHARACTERISTICS (See Notes 1, 2, and 3)

| ldent. | Characteristic | Symbol | MC6840 | | MC68A40 | | MC68B40 | | Unit |
|--------|-----------------------------------|---------------------------------|--------|------|---------|------|---------|------|------|
| Number | Characteristic | Symbol | Min | Max | Min | Max | Min | Max | Unit |
| 1 1 | Cycle Time | tcyc | 10 | 10 | 0 67 | 10 | 05 | 10 | μS |
| 2 | Pulse Width, E Low | PWEL | 430 | 9500 | 280 | 9500 | 210 | 9500 | ns |
| 3 | Pulse Width, E High | PWEH | 450 | 9500 | 280 | 9500 | 220 | 9500 | ns |
| 4 | Clock Rise and Fall Time | t _r , t _f | - | 25 | - | 25 | - | 20 | ns |
| 9 | Address Hold Time | ^t AH | 10 | | 10 | _ | 10 | _ | ns |
| 13 | Address Setup Time Before E | tAS | 80 | - | 60 | - | 40 | - | ns |
| 14 | Chip Select Setup Time Before E | tcs | 80 | - | 60 | - | 40 | _ | ns |
| 15 | Chip Select Hold Time | tCH | 10 | _ | 10 | - | 10 | - | ns |
| 18 | Read Data Hold Time | ^t DHR | 20 | 50° | 20 | 50* | 20 | 50° | ns |
| 21 | Write Data Hold Time | tDHW | 10 | _ | 10 | - | 10 | _ | ns |
| 30 | Peripheral Output Data Delay Time | tDDR | - | 290 | _ | 180 | _ | 150 | ns |
| 31 | Peripheral Input Data Setup Time | tDSW | 165 | | 80 | - | 60 | _ | ns |

^{*}The data bus output buffers are no longer sourcing or sinking current by tDHR max (High Impedance)

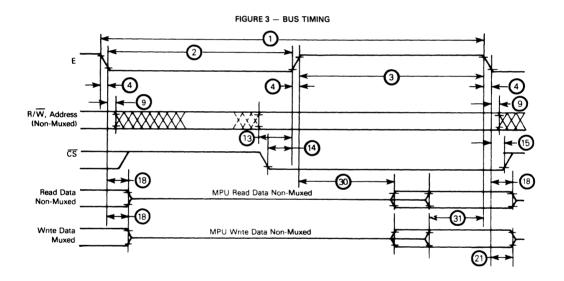


FIGURE 4 - INPUT PULSE WIDTH LOW

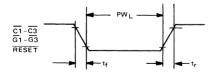
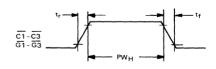
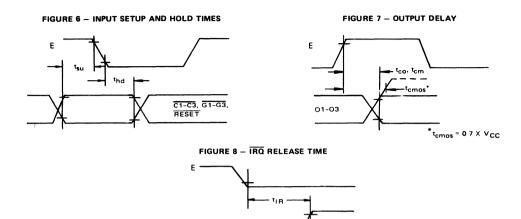


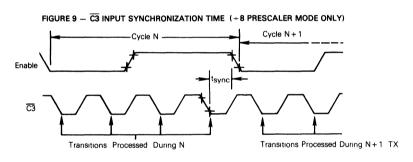
FIGURE 5 - INPUT PULSE WIDTH HIGH

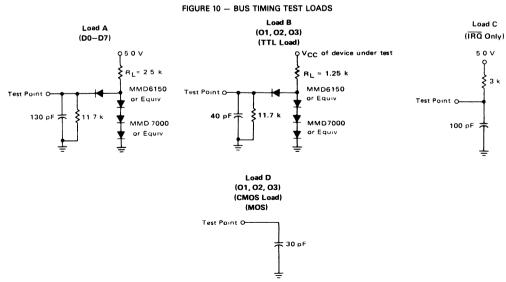


NOTES

- 1 Not all signals are applicable to every part
- 2 Voltage levels shown are V_L≤0 4 V, V_H≥2 4 V, unless otherwise specified 3 Measurement points shown are 0 8 V and 2 0 V, unless otherwise specified







NOTE Timing measurements are referenced to and from a low voltage of 0.8 volts and a high voltage of 2.0 volts, unless otherwise noted

MC6840 MC68A40 MC68B40

DEVICE OPERATION

The MC6840 is part of the M6800 microprocessor family and is fully bus compatible with M6800 systems. The three timers in the MC6840 operate independently and in several distinct modes to fit a wide variety of measurement and synthesis applications

The MC6840 is an integrated set of three distinct counter/timers (Figure 1). It consists of three 16-bit data latches, three 16-bit counters (clocked independently), and the comparison and enable circuitry necessary to implement various measurement and synthesis functions. In addition, it contains interrupt drivers to alert the processor that a particular function has been completed.

In a typical application, a timer will be loaded by first storing two bytes of data into an associated Counter Latch. This data is then transferred into the counter via a Counter Initialization cycle. If the counter is enabled, the counter decrements on each subsequent clock period which may be an external clock, or Enable (E) until one of several predetermined conditions causes it to halt or recycle. The timers are thus programmable, cyclic in nature, controllable by external inputs or the MPU program, and accessible by the MPU at any time.

BUS INTERFACE

The Programmable Timer Module (PTM) interfaces to the M6800 Bus with an 8-bit bidirectional data bus, two Chip Select lines, a Read/Write line, a clock (Enable) line, and Interrupt Request line, an external Reset line, and three Register select lines VMA should be utilized in conjunction with an MPU address line into a Chip Select of the PTM when using the MC6800/6802/6808.

BIDIRECTIONAL DATA (D0-D7) — The bidirectional data lines (D0-D7) allow the transfer of data between the MPU and PTM. The data bus output drivers are three-state devices which remain in the high-impedance (off) state except when the MPU performs a PTM read operation (Read/Write and Enable lines high and PTM Chip Selects activated).

CHIP SELECT (\overline{CSO} , CS1) — These two signals are used to activate the Data Bus interface and allow transfer of data from the PTM With $\overline{CSO} = 0$ and CS1=1, the device is selected and data transfer will occur

READ/WRITE (R/\overline{W}) — This signal is generated by the MPU to control the direction of data transfer on the Data Bus With the PTM selected, a low state on the PTM R/\overline{W} line enables the input buffers and data is transferred from the MPU to the PTM on the trailing edge of the E (Enable) clock Alternately, (under the same conditions) $R/\overline{W}=1$ and Enable high allows data in the PTM to be read by the MPU.

ENABLE (E CLOCK) — The E clock signal synchronizes data transfer between the MPU and the PTM. It also performs an equivalent synchronization function on the external clock, reset, and gate inputs of the PTM.

INTERRUPT REQUEST (\overline{IRQ}) — The active low Interrupt Request signal is normally tied directly (or through priority interrupt circuitry) to the \overline{IRQ} input of the MPU. This is an

"open drain" output (no load device on the chip) which permits other similar interrupt request lines to be tied together in a wire-OR configuration

The $\overline{\text{IRQ}}$ line is activated if, and only if, the Composite Interrupt Flag (Bit 7 of the Internal Status Register) is asserted The conditions under which the $\overline{\text{IRQ}}$ line is activated are discussed in conjunction with the Status Register

RESET — A low level at this input is clocked into the PTM by the E (Enable) input. Two Enable pulses are required to synchronize and process the signal. The PTM then recognizes the active "low" or inactive "high" on the third Enable pulse. If the RESET signal is asynchronous, an additional Enable period is required if setup times are not met. The RESET input must be stable High/Low for the minimum time stated in the AC Operating Characteristics.

Recognition of a low level at this input by the PTM causes the following action to occur

- a All counter latches are preset to their maximum count values
- All Control Register bits are cleared with the exception of CR10 (internal reset bit) which is set
- c All counters are preset to the contents of the latches
- d All counter outputs are reset and all counter clocks are disabled
- e All Status Register bits (interrupt flags) are cleared

REGISTER SELECT LINES (RS0, RS1, RS2) — These inputs are used in conjunction with the R/\overline{W} line to select the internal registers, counters and latches as shown in Table 1

NOTE:

The PTM is accessed via MPU Load and Store operations in much the same manner as a memory device. The instructions available with the M6800 family of MPUs which perform read-modify-write operations on memory should not be used when the PTM is accessed. These instructions actually fetch a byte from memory, perform an operation, then restore it to the same address location. Since the PTM uses the R/W line as an additional register select input, the modified data will not be restored to the same register if these instructions are used.

CONTROL REGISTER

Each timer in the MC6840 has a corresponding write-only Control Register Control Register #2 has a unique address space (RS0=1, RS=0, RS2=0) and therefore may be written into at any time. The remaining Control Registers (#1 and #3) share the Address Space selected by a logic zero on all Register Select inputs

CR20 — The least-significant bit of Control Register #2 (CR20) is used as an additional addressing bit for Control Registers #1 and #3 Thus, with all Register selects and R/W inputs at logic zero, Control Register #1 will be written into if CR20 is a logic one. Under the same conditions, Control Register #3 can also be written into after a RESET low condition has occurred, since all control register bits (except CR10) are cleared. Therefore, one may write in the sequence CR3, CR2, CR1

TABLE 1 - REGISTER SELECTION

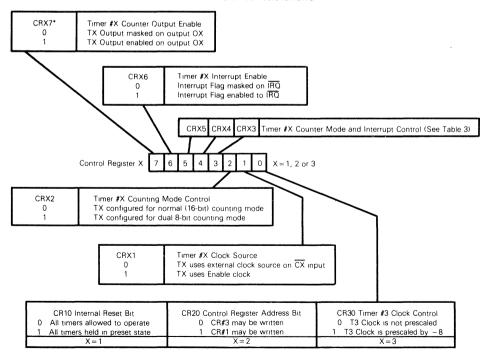
| Register Select Inputs | | | Operations | | | |
|---------------------------|-----|-----|------------------------------------|--------------------------|--|--|
| RS2 | RS1 | RS0 | R/W = 0 | R/W = 1 | | |
| 0 | 0 | 0 | CR20 = 0 Write Control Register #3 | No Operation | | |
| | | _ | CR20 = 1 Write Control Register #1 | | | |
| 0 | 0 | 1 | Write Control Register #2 | Read Status Register | | |
| 0 | 1 | 0 | Write MSB Buffer Register | Read Timer #1 Counter | | |
| 0 | 1 | 1 | Write Timer #1 Latches | Read LSB Buffer Register | | |
| 1 | 0 | 0 | Write MSB Buffer Register | Read Timer #2 Counter | | |
| 1 | 0 | 1 | Write Timer #2 Latches | Read LSB Buffer Register | | |
| 1 | 1 | 0 | Write MSB Buffer Register | Read Timer #3 Counter | | |
| 1 | 1 | 1 | Write Timer #3 Latches | Read LSB Buffer Register | | |

CR10 — The least-significant bit of Control Register #1 is used as an Internal Reset bit. When this bit is a logic zero, all timers are allowed to operate in the modes prescribed by the remaining bits of the control registers. Writing a "one" into CR10 causes all counters to be preset with the contents of the corresponding counter latches, all counter clocks to be disabled, and the timer outputs and interrupt flags (Status Register) to be reset. Counter Latches and Control Registers are undisturbed by an Internal Reset and may be written into regardless of the state of CR10.

The least-significant bit of Control Register #3 is used as a selector for a -8 prescaler which is available with Timer #3 only. The prescaler, if selected, is effectively placed between the clock input circuitry and the input to Counter #3. It can therefore be used with either the internal clock (Enable) or an external clock source.

CR30 — The functions depicted in the foregoing discussions are tabulated in Table 2 for ease of reference

TABLE 2 - CONTROL REGISTER BITS



Control Register Bits CR10, CR20, and CR30 are unique in that each selects a different function. The remaining bits (1 through 7) of each Control Register select common functions, with a particular Control Register affecting only its corresponding timer

CRX1 - Bit 1 of Control Register #1 (CR11) selects whether an internal or external clock source is to be used with Timer #1 Similarly, CR21 selects the clock source for Timer #2, and CR31 performs this function for Timer #3 The function of each bit of Control Register "X" can therefore be defined as shown in the remaining section of Table 2

CRX2 - Control Register Bit 2 selects whether the binary information contained in the Counter Latches (and subsequently loaded into the counter) is to be treated as a single 16-bit word or two 8-bit bytes. In the single 16-bit Counter Mode (CRX2=0) the counter will decrement to zero after N+1 enabled (G=0) clock periods, where N is defined as the 16-bit number in the Counter Latches With CRX2=1, a similar Time Out will occur after (L+1) • (M+1) enabled clock periods, where L and M, respectively, refer to the LSB and MSB bytes in the Counter Latches

CRX3-CRX7 - Control Register Bits 3, 4, and 5 are explained in detail in the Timer Operating Mode section Bit 6 is an interrupt mask bit which will be explained more fully in conjunction with the Status Register, and bit 7 is used to enable the corresponding Timer Output A summary of the control register programming modes is shown in Table 3

STATUS REGISTER/INTERRUPT FLAGS

The MC6840 has an internal Read-Only Status Register which contains four Interrupt Flags (The remaining four bits of the register are not used, and defaults to zeros when being read) Bits 0, 1, and 2 are assigned to Timers 1, 2, and 3, respectively, as individual flag bits, while Bit 7 is a Composite Interrupt Flag This flag bit will be asserted if any of the individual flag bits is set while Bit 6 of the corresponding Control Register is at a logic one. The conditions for asserting the composite Interrupt Flag bit can therefore be expressed

> INT = I1 • CR16 + I2 • CR26 + I3 • CR36 where INT = Composite Interrupt Flag (Bit 7) I1 = Timer #1 Interrupt Flag (Bit 0)

12 = Timer #2 Interrupt Flag (Bit 1)

I3= Timer #3 Interrupt Flag (Bit 2)

An interrupt flag is cleared by a Timer Reset condition, i.e., External RESET = 0 or Internal Reset Bit (CR10) = 1. It will also be cleared by a Read Timer Counter Command provided that the Status Register has previously been read while the interrupt flag was set. This condition on the Read Status Register-Read Timer Counter (RS-RT) sequence is designed to prevent missing interrupts which might occur after the status register is read, but prior to reading the Timer Counter

An Individual Interrupt Flag is also cleared by a Write Timer Latches (W) command or a Counter Initialization (CI) sequence, provided that W or CI affects the Timer corresponding to the individual Interrupt Flag

COUNTER LATCH INITIALIZATION

Each of the three independent timers consists of a 16-bit addressable counter and a 16-bit addressable latch. The counters are preset to the binary numbers stored in the latches Counter initialization results in the transfer of the latch contents to the counter See notes in Table 4 regarding the binary number N, L, or M placed into the Latches and their relationship to the output waveforms and counter Time-Outs

Since the PTM data bus is 8-bits wide and the counters are 16-bits wide, a temporary register (MSB Buffer Register) is provided This "write only" register is for the Most-Significant Byte of the desired latch data. Three addresses are provided for the MSB Buffer Register (as indicated in Table 1), but they all lead to the same Buffer Data from the MSB Buffer will automatically be transferred into the Most-Significant Byte of Timer #X when a Write Timer #X Latches Command is performed. So it can be seen that the MC6840 has been designed to allow transfer of two bytes of data into the counter latches provided that the MSB is transferred first. The storage order must be observed to ensure proper latch operation

In many applications, the source of the data will be an M6800 Family MPU It should be noted that the 16-bit store operations of the M6800 family microprocessors (STS and STX) transfer data in the order required by the PTM A Store Index Register Instruction, for example, results in the MSB of the X register being transferred to the selected address, then the LSB of the X register being written into the next higher location. Thus, either the index register or stack pointer may be transferred directly into a selected counter latch with a single instruction

A logic zero at the RESET input also initializes the counter latches in this case, all latches will assume a maximum count of 65,535₁₀ It is important to note that an Internal

CRX4 TABLE 3 - PTM OPERATING MODE SELECTION CRX5 CRX3-0 0 Continuous Operating Mode Gate I or Write to Latches or Reset Causes Counter Initialization 0 0 1 Frequency Comparison Mode Interrupt If Gate Is Counter Time Out 0 1 0 Continuous Operating Mode Gate I or Reset Causes Counter Initialization 0 1 1 Pulse Width Comparison Mode Interrupt if Gate 4 is < Counter Time Out 1 0 0 Single Shot Mode Gate I or Write to Latches or Reset Causes Counter Initialization 1 0 1 Frequency Comparison Mode Interrupt If Gate sis> Counter Time Out 1 1 0 Single Shot Mode Gate I or Reset Causes Counter Initialization 1 1 1 Pulse Width Comparison Mode Interrupt If Gate s>Counter Time Out

Reset (Bit zero of Control Register 1 Set) has no effect on the counter latches.

COUNTER INITIALIZATION

Counter Initialization is defined as the transfer of data from the latches to the counter with subsequent clearing of the Individual Interrupt Flag associated with the counter. Counter Initialization always occurs when a reset condition (RESET = 0 or CR10 = 1) is recognized. It can also occur — depending on Timer Mode — with a Write Timer Latches command or recognition of a negative transition of the Gate input.

Counter recycling or re-initialization occurs when a negative transition of the clock input is recognized after the counter has reached an all-zero state. In this case, data is transferred from the Latches to the Counter

ASYNCHRONOUS INPUT/OUTPUT LINES

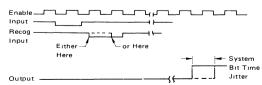
Each of the three timers within the PTM has external clock and gate inputs as well as a counter output line. The inputs are high-impedance, TTL-compatible lines and ouputs are capable of driving two standard TTL loads.

CLOCK INPUTS (C1, C2, and C3) — Input pins C1, C2, and C3 will accept asynchronous TTL voltage level signals to decrement Timers 1, 2, and 3, respectively The high and low levels of the external clocks must each be stable for at least one system clock period plus the sum of the setup and hold times for the clock inputs The asynchronous clock rate can vary from dc to the limit imposed by the Enable Clock Setup, and Hold times

The external clock inputs are clocked in by Enable pulses Three Enable periods are used to synchronize and process the external clock. The fourth Enable pulse decrements the internal counter. This does not affect the input frequency, it merely creates a delay between a clock input transition and internal recognition of that transition by the PTM All references to C inputs in this document relate to internal recognition of the input transition. Note that a clock high or low level which does not meet setup and hold time specifications may require an additional Enable pulse for recognition When observing recurring events, a lack of synchronization will result in "jitter" being observed on the output of the PTM when using asynchronous clocks and gate input signals. There are two types of jitter "System jitter" is the result of the input signals being out of synchronization with Enable, permitting signals with marginal setup and hold time to be recognized by either the bit time nearest the input transition or the subsequent bit time

"Input jitter" can be as great as the time between input signal negative going transitions plus the system jitter, if the first transition is recognized during one system cycle, and not recognized the next cycle, or vice versa. See Figure 11

FIGURE 11 - INPUT JITTER



CLOCK INPUT $\overline{\textbf{C3}}$ (-8 **PRESCALER MODE**) — External clock input $\overline{\textbf{C3}}$ represents a special case when Timer #3 is programmed to utilize its optional –8 prescaler mode

The divide-by-8 prescaler contains an asynchronous ripple counter, thus, input setup (t_{SU}) and hold times (t_{hd}) do not apply. As long as minimum input pulse widths are maintained, the counter will recognize and process all input clock ($\overline{C3}$) transitions. However, in order to guarantee that a clock transition is processed during the current E cycle, a certain amount of synchronization time (t_{SYNC}) is required between the $\overline{C3}$ transition and the falling edge of Enable (see Figure 9). If the synchronization time requirement is not met, it is possible that the $\overline{C3}$ transition will not be processed until the following E cycle.

The maximum input frequency and allowable duty cycles for the -8 prescaler mode are specified under the AC Operating Characteristics Internally, the -8 prescaler output is treated in the same manner as the previously discussed clock inputs

GATE INPUTS $\overline{(\mathbf{G1})}$, $\overline{(\mathbf{G2})}$, $\overline{(\mathbf{G3})}$ — Input pins $\overline{(\mathbf{G1})}$, $\overline{(\mathbf{G2})}$, and $\overline{(\mathbf{G3})}$ accept asynchronous TTL-compatible signals which are used as triggers or clock gating functions to Timers 1, 2, and 3, respectively. The gating inputs are clocked into the PTM by the E (enable) clock in the same manner as the previously discussed clock inputs. That is, a Gate transition is recognized by the PTM on the fourth Enable pulse (provided setup and hold time requirements are met), and the high or low levels of the Gate input must be stable for at least one system clock period plus the sum of setup and hold times. All references to G transition in this document relate to internal recognition of the input transition.

The Gate inputs of all timers directly affect the internal 16-bit counter. The operation of $\overline{G3}$ is therefore independent of the -8 prescaler selection

TIMER OUTPUTS (01, 02, 03) — Timer outputs 01, 02, and 03 are capable of driving up to two TTL loads and produce a defined output waveform for either Continuous or Single-Shot Timer modes Output waveform definition is accomplished by selecting either Single 16-bit or Dual 8-bit operating modes. The Single 16-bit mode will produce a square-wave output in the continuous mode and a single pulse in the single-shot mode. The Dual 8-bit mode will produce a variable duty cycle pulse in both the continuous and single-shot timer modes. One bit of each Control Register (CRX7) is used to enable the corresponding output. If this bit is cleared, the output will remain low (VoL) regardless of the operating mode. If it is cleared while the output is high the output will go low during the first enable cycle following a write to the Control Register.

The Continuous and Single-Shot Timer Modes are the only ones for which output response is defined in this data sheet Refer to the Programmable Timer Fundamentals and Applications manual for a discussion of the output signals in other modes Signals appear at the outputs (unless CRX7=0) during Frequency and Pulse Width comparison modes, but the actual waveform is not predictable in typical applications

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TIMER OPERATING MODES

The MC6840 has been designed to operate effectively in a wide variety of applications. This is accomplished by using three bits of each control register (CRX3, CRX4, and CRX5) to define different operating modes of the Timers. These modes are divided into WAVE SYNTHESIS and WAVE MEASUREMENT modes, and are outlined in Table 4.

TABLE 4 - OPERATING MODES

| Con | trol Regi | ster | T 0 | i |
|------|-----------|------|------------------------|-------------|
| CRX3 | CRX4 | CRX5 | Timer Operating Mode | |
| 0 | • | 0 | Continuous | 6 |
| 0 | • | 1 | Single-Shot | Synthesizer |
| 1 | 0 | • | Frequency Comparison | |
| 1 | 1 | • | Pulse Width Comparison | Measurement |

^{*}Defines Additional Timer Function Selection

One of the WAVE SYNTHESIS modes is the Continuous Operating mode, which is useful for cyclic wave generation Either symmetrical or variable duty-cycle waves can be generated in this mode. The other wave synthesis mode, the Single-Shot mode, is similar in use to the Continuous operating mode, however, a single pulse is generated, with a programmable preset width

The WAVE MEASUREMENT modes include the Frequency Comparison and Pulse Width Comparison modes which are used to measure cyclic and singular pulse widths, respectively

In addition to the four timer modes in Table 4, the remaining control register bit is used to modify counter initialization and enabling or interrupt conditions

WAVE SYNTHESIS MODES

CONTINUOUS OPERATING MODE (TABLE 5) — The continuous mode will synthesize a continuous wave with a period proportional to the preset number in the particular timer latches. Any of the timers in the PTM may be programed to operate in a continuous mode by writing zeroes into bits 3 and 5 of the corresponding control register. Assuming

that the timer output is enabled (CRX7=1), either a square wave or a variable duty cycle waveform will be generated at the Timer Output, OX. The type of output is selected via Control Register Bit 2.

Either a Timer Reset (CR10=1 or External Reset=0) condition or internal recognition of a negative transition of the Gate input results in Counter Initialization. A Write Timer latches command can be selected as a Counter Initialization signal by clearing CRX4

The counter is enabled by an absence of a Timer Reset condition and a logic zero at the Gate input. In the 16-bit mode, the counter will decrement on the first clock cycle during or after the counter initialization cycle. It continues to decrement on each clock signal so long as G remains low and no reset condition exists. A Counter Time Out (the first clock after all counter bits = 0) results in the Individual Interrupt Flag being set and reinitialization of the counter.

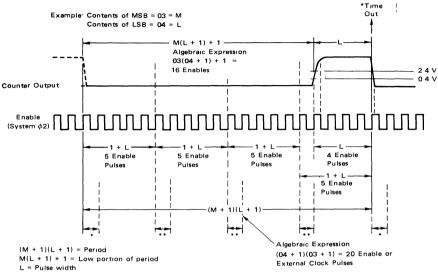
In the Dual 8-bit mode (CRX2=1) [refer to the example in Figure 12 and Tables 5 and 6] the MSB decrements once for every full countdown of the LSB+1 When the LSB=0, the MSB is unchanged, on the next clock pulse the LSB is reset to the count in the LSB Latches, and the MSB is decremented by 1 (one) The output, if enabled, remains low during and after initialization and will remain low until the counter MSB is all zeroes. The output will go high at the beginning of the next clock pulse. The output remains high until both the LSB and MSB of the counter are all zeroes. At the beginning of the next clock pulse the defined Time Out (TO) will occur and the output will go low. In the Dual 8-bit mode the period of the output of the example in Figure 12 would span 20 clock pulses as opposed to 1546 clock pulses using the normal 16-bit mode.

A special time-out condition exists for the dual 8-bit mode (CRX2=1) if L=0. In this case, the counter will revert to a mode similar to the single 16-bit mode, except Time Out occurs after M+1* clock pulses. The output, if enabled, goes low during the Counter Initialization cycle and reverses state at each Time Out. The counter remains cyclical (is reinitialized at each Time Out) and the Individual Interrupt Flag is set when Time Out occurs. If M=L=0, the internal counters do not change, but the output toggles at a rate of ½ the clock frequency.

TABLE 5 - CONTINUOUS OPERATING MODES

| | | | ONTINUOUS MODE CRX3 = 0, CRX5 = 0) |
|------------------|-------------------------------|--------|---|
| Control Register | | | Initialization/Output Waveforms |
| CRX2 | 2 CRX4 Counter Initialization | | *Timer Output (OX) (CRX7 = 1) |
| 0 | 0 | Ḡ↓+w+R | -(N+1)(T) -(N+1)(T) - (N+1)(T) - V _{OH} |
| 0 | 1 | Ğ↓+R | 1 ₀ TO TO TO |
| 1 | 0 | Ḡ↓+w+R | (L+1)(M+1)(T)————(L+1)(M+1)(T)————V _{OH} |
| 1 | 1 | Ğ↓+R | (L)(T) - (L)(T) - VOL |

FIGURE 12 — TIMER OUTPUT WAVEFORM EXAMPLE (Continuous Dual 8-Bit Mode Using Internal Enable)



^{*}Preset LSB and MSB to Respective Latches on the negative transition of the Enable

The discussion of the Continuous Mode has assumed that the application requires an output signal. It should be noted that the Timer operates in the same manner with the output disabled (CRX7=0). A Read Timer Counter command is valid regardless of the state of CRX7

SINGLE-SHOT TIMER MODE — This mode is identical to the Continuous Mode with three exceptions. The first of these is obvious from the name — the output returns to a low level after the initial Time. Out and remains low until another Counter Initialization cycle occurs.

As indicated in Table 6, the internal counting mechanism remains cyclical in the Single-Shot Mode Each Time Out of

the counter results in the setting of an Individual Interrupt Flag and re-initialization of the counter

The second major difference between the Single-Shot and Continuous modes is that the internal counter enable is not dependent on the Gate input level reamining in the low state for the Single-Shot mode

Another special condition is introduced in the Single-Shot mode. If L=M=0 (Dual 8-bit) or N=0 (Single 16-bit), the output goes low on the first clock received during or after Counter Initialization. The output remains low until the Operating Mode is changed or nonzero data is written into the Counter Latches. Time Outs continue to occur at the end of each clock period.

TABLE 6 - SINGLE-SHOT OPERATING MODES

| Synthesis Modes | | SINGLE-SHOT MODE (CRX3 = 0, CRX7 = 1, CRX5 = 1) | | | | |
|-----------------|----------|--|---|--|--|--|
| Control | Register | | Initialization/Output Waveforms | | | |
| CRX2 | CRX4 | Counter Initialization | Timer Output (OX) | | | |
| 0 | 0 | Ḡ↓+W+R | (N+1)(T) (N+1)(T) (N+1)(T) | | | |
| 0 | 1 | Ğ↓+R | t _o TO TO | | | |
| 1 | 0 | G↓+W+R | (L+1)(M+1)(T) (L+1)(M+1)(T) (L+1)(M+1)(T) | | | |
| 1 | 1 | Ğ↓+R | t ₀ TO TO | | | |

Symbols are as defined in Table 5.

^{**}Preset LSB to LSB Latches and Decrement MSB by one on the negative transition of the Enable

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The three differences between Single-Shot and Continous Timer Mode can be summarized as attributes of the Single-Shot mode

- 1. Output is enabled for only one pulse until it is reinitialized
 - 2. Counter Enable is independent of Gate
 - 3 L= M = 0 or N = 0 disables output

Aside from these differences, the two modes are identical

WAVE MEASUREMENT MODES

TIME INTERVAL MODES — The Time Interval Modes are the Frequency (period) Measurement and Pulse Width Comparison Modes, and are provided for those applications which require more flexibility of interrupt generation and Counter Initialization Individual Interrupt Flags are set in these modes as a function of both Counter Time Out and transitions of the Gate input Counter Initialization is also affected by Interrupt Flag status

A timer's output is normally not used in a Wave Measurement mode, but it is defined if the output is enabled, it will operate as follows. During the period between reinitialization of the timer and the first Time Out, the output will be a logical zero. If the first Time Out is completed (regardless of its method of generation), the output will go high. If further TO's occur, the output will change state at each completion of a Time-Out.

The counter does operate in either Single 16-bit or Dual 8-bit modes as programmed by CRX2 Other features of the Wave Measurement Modes are outlined in Table 7

Frequency Comparison Or Period Measurement Mode (CRX3=1, CRX4=0) — The Frequency Comparison Mode with CRX5=1 is straightforward If Time Out occurs prior to the first negative transition of the Gate input after a Counter Initialization cycle, and Individual Interrupt Flag is set The counter is disabled, and a Counter Initialization cycle cannot begin until the interrupt flag is cleared and a negative transition on $\overline{\Omega}$ is detected

If CRX5=0, as shown in Tables 7 and 8, an interrupt is generated if \overline{Gate} input returns low prior to a Time Out If a Counter Time Out occurs first, the counter is recycled and continues to decrement A bit is set within the timer on the initial Time Out which precludes further individual interrupt

generation until a new Counter Initialization cycle has been completed. When this internal bit is set, a negative transition of the Gate input starts a new Counter Initialization cycle (The condition of $\overline{G1} \cdot \overline{1} \cdot \overline{1} \cdot \overline{1}$) is satisfied, since a Time Out has occurred and no individual Interrupt has been generated.)

Any of the timers within the PTM may be programmed to compare the period of a pulse (giving the frequency after calculations) at the Gate input with the time period requested for Counter Time Out. A negative transition of the Gate Input enables the counter and starts a Counter Initialization cycle — provided that other conditions, as noted in Table 8, are satisfied. The counter decrements on each clock signal recognized during or after Counter Initialization until an Interrupt is generated, a Write Timer Latches command is issued, or a Timer Reset condition occurs. It can be seen from Table 8 that an interrupt condition will be generated if CRX5=0 and the period of the pulse (single pulse or measured separately repetitive pulses) at the Gate input is less than the Counter Time Out period. If CRX5=1, an interrupt is generated if the reverse is true.

Assume now with CRX5=1 that a Counter Initialization has occurred and that the Gate input has returned low prior to Counter Time Out. Since there is no Individual Interrupt Flag generated, this automatically starts a new Counter Initialization Cycle. The process will continue with frequency comparison being performed on each Gate input cycle until the mode is changed, or a cycle is determined to be above the predetermined limit.

Pulse Width Comparison Mode (CRX3=1, CRX4=1) — This mode is similar to the Frequency Comparison Mode except for a positive, rather than negative, transition of the Gate input termintes the count With CRX5=0, an Individual Interrupt Flag will be generated if the zero level pulse applied to the Gate input is less than the time period required for Counter Time Out With CRX5=1, the interrupt is generated when the reverse condition is true

As can be seen in Table 8, a positive transition of the Gate input disables the counter With CRX5=0, it is therefore possible to directly obtain the width of any pulse causing an interrupt. Similar data for other Time Interval Modes and conditions can be obtained, if two sections of the PTM are dedicated to the purpose

FIGURE 7 - OUTPUT DELAY

| | CRX3 = 1 | | | | | | | |
|---|----------|------------------------|--|--|--|--|--|--|
| CRX4 CRX5 Application Condition for Setting Individual Intere | | | | | | | | |
| Þ | 0 | Frequency Comparison | Interrupt Generated if Gate Input Period (1/F) is less than Counter Time Out (TO) | | | | | |
| 0 | 1 | Frequency Comparison | Interrupt Generated if Gate Input Period (1/F) is greater than Counter Time Out (TO) | | | | | |
| 1 | 0 | Pulse Width Comparison | Interrupt Generated if Gate Input "Down Time" is less than Counter Time Out (TO) | | | | | |
| 1 | 1 | Pulse Width Comparison | Interrupt Generated if Gate Input "Down Time" is greater than Counter Time Out (TO) | | | | | |

TABLE 8 - FREQUENCY COMPARISON MODE

| Mode | Bit 3 | Bit 4 | Control Reg. Bit 5 | Counter Initialization | Counter Enable Flip-Flop Set (CE) | Counter Enable Flip-Flop Reset (CE) | Interrupt Flag Set (I) |
|-------------|-------|-------|-----------------------|---------------------------|--------------------------------------|--|---------------------------|
| Frequency | 1 | 0 | 0 | GI+I±(CE+TO)+R | GI•W•R•I | W+R+I | GI Before TO |
| Comparison | 1 | 0 | 1 | GI•T+R | GI•W•R•I | W+R+I | TO Before GI |
| Pulse Width | 1 | 1 | 0 | GI•T+R | GIW•R•T | W+R+I+G | G1 Before TO |
| Comparison | 1 | 1 | 1 | GI•T+R | GI•W•R•T | W+R+I+G | Gt Before TO |

GI = Negative transition of Gate input

W = Write Timer Latches Command

R = Timer Reset (CR10=1 or External RESET = 0)
N = 16-Bit Number in Counter Latch

TO = Counter Time Out (All Zero Condition)

I = Interrupt for a given timer

^{*}All time intervals shown above assume the Gate (\overrightarrow{G}) and Clock (\overrightarrow{C}) signals are sycnhronized to the system clock

⁽E) with the specified setup and hold time requirements



MC6843

FLOPPY DISK CONTROLLER (FDC)

The MC6843 Floppy Disk Controller performs the complex MPU/Floppy interface function. The FDC was designed to optimize the balance between Hardware and Software in order to achieve integration of all key functions and maintain flexibility.

The FDC can interface a wide range of drives with a minimum of external hardware. Multiple drives can be controlled with the addition of external multiplexing rather than additional FDCs.

- Format Compatible with IBM 3740
- User Programmable Read/Write Format
- Ten Powerful Macro Commands
- Macro-End Interrupt Allows Parallel Processing of MPU and FDC
- Controls Multiple Floppies with External Multiplexing
- Direct Interface with M6800 Bus
- Programmable Step and Settling Times Enable Operation with a Wide Range of Floppy Drives
- Offers Both Program Controlled I/O (PCIO) and DMA Data Transfer Mode
- · Free-Format Read or Write
- Single 5-Volt Power Supply
- All Registers Directly Accessible

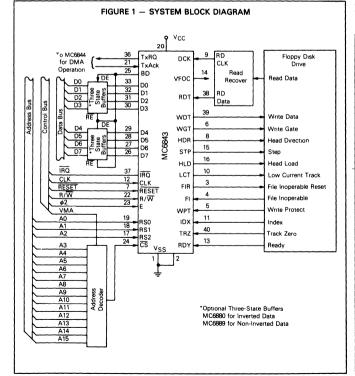
MOS

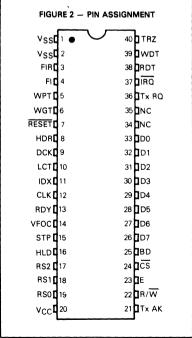
(N-CHANNEL, SILICON-GATE)

FLOPPY DISK CONTROLLER



P SUFFIX
PLASTIC PACKAGE
CASE 711





MAXIMUM RATING

| Rating | Symbol | Value | Unit |
|-----------------------------|------------------|----------------|------|
| Supply Voltage | Vcc | -0.3 to $+7.0$ | ٧ |
| Input Voltage | V _{in} | -0.3 to $+7.0$ | ٧ |
| Operating Temperature Range | TA | 0 to +70 | °C |
| Storage Temperature Range | T _{stg} | -55 to +150 | °C |

THERMAL CHARACTERISTICS

| Characteristic | Symbol | Value | Rating |
|--------------------|-------------------|-------|--------|
| Thermal Resistance | $\theta_{\sf JA}$ | 100 | °C/W |

This device contains circuitry to protect the inputs against damage due to high static voltages or electric fields, however, it is advised that normal precautions be taken to avoid application of any voltage higher than maximum rated voltages to this high-impedance circuit. Reliability of operation is enhanced if unused inputs are tied to an appropriate logic voltage level (e.g., either VSS or VCC)

POWER CONSIDERATIONS

The average chip-junction temperature, T_J, in °C can be obtained from:

$$T_{J} = T_{A} + (P_{D} \bullet \theta_{J} A)$$
Where:

T_A = Ambient Temperature, °C

θ JA = Package Thermal Resistance, Junction-to-Ambient, °C/W

PD = PINT + PPORT

PINT≡ICC×VCC, Watts — Chip Internal Power

PPORT ■ Port Power Dissipation, Watts - User Determined

For most applications PPORT ◀PINT and can be neglected. PPORT may become significant if the device is configured to drive Darlington bases or sink LED loads.

An approximate relationship between PD and TJ (if PPORT is neglected) is:

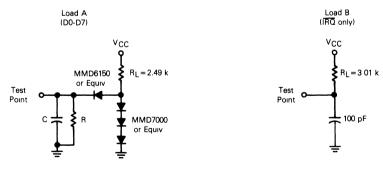
$$P_D = K + (T_J + 273^{\circ}C)$$
 (2)

Solving equations 1 and 2 for K gives:

 $K = PD \bullet (TA + 273 \circ C) + \theta_{JA} \bullet PD^2$

Where K is a constant pertaining to the particular part. K can be determined from equation 3 by measuring PD (at equilibrium) for a known T_A . Using this value of K the values of PD and T_J can be obtained by solving equations (1) and (2) iteratively for any value of T_A

FIGURE 3 - TEST LOADS



C=130 pF for D0-D7 = 30 pF for HLD, STP, HDR, LCT, WGT, FIR TxRQ, BD R=11 7 k for D0-D7 = 24 k for HLD, STP, HDR, LCR, LCT, WGT, FIR TxRQ, BD

DC ELECTRICAL CHARACTERISTICS ($V_{CC} = 5.0 \text{ Vdc } \pm 5\%$, $V_{SS} = 0$, $T_A = 0$ to 70°C unless otherwise noted)

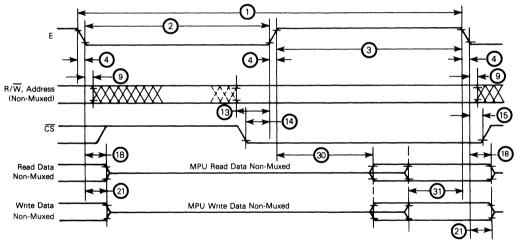
| Characteristic | Symbol | Min | Тур | Max | Unit |
|---|---------------------------------|--|-------------|---------------------|------|
| Input High Voltage | VIH | V _{SS} +20 | _ | Vcc | V |
| Input Low Voltage | VIL | V _{SS} -03 | _ | V _{SS} +08 | V |
| Input Leakage Current (V _{In} = 0 to 5 5 V) | lin | _ | 10 | 25 | μΑ |
| Three-State Input Leakage Current (V _{ID} = 0 4 to 2 4 V, V _{CC} = 5 5 V) D0-D | | - 10 | 2.0 | 10 | μΑ |
| Output High Voltage | | | 1 | <u> </u> | |
| $(I_{load} = -205 \mu\text{A}) \qquad \qquad D0-D$ | , 0,, | VSS+24 | - | - | V |
| $(I_{load} = -100 \mu\text{A})$ Other Output | | V _{SS} +24 | | _ | |
| Output Low Voltage (I _{load} = 1.6 mA) | VOL | | _ | Vss+0.4 | V |
| Three-State Output Leakage Current (V _{OH} = 2 4 V) IR | loz | | 10 | 10 | μΑ |
| Internal Power Dissipation (Measured at $T_A = T_L$ to T_H) | PINT | | | 750 | mW |
| Input Capacitance $(V_{In}=0\ V,\ f=1\ 0\ MHz,\ T_{\mbox{A}}=25\ ^{\circ}\mbox{C}) \label{eq:constraint}$ Enable D0-D All Other | 7 Cin | - - - | - - - | 10 12 5 10 | pF |
| Output Capacitance (V _{In} = 0 V, f = 1 0 MHz, T _A = 25°C) All Output | s C _{out} | _ | _ | 10 | pF |
| Clock Pulse Width, Low (CLK) | PWCL | 400 | - | - | ns |
| Clock Pulse Width, High (CLK) | PWCH | 400 | | _ | ns |
| Master Clock Period (CLK) | tMC | 10 | - | _ | μS |
| Data Clock Pulse Width, Low (DCK) | PWDL | 13 | 1 95 | _ | μS |
| Data Clock Pulse Width, High (DCK) | PWDH | 13 | 1 95 | _ | μS |
| Data Clock Period (DCK) | tDC | 2.5 | 40 | _ | μS |
| Read Data to Data Clock Delay Time 1 | tRDD1 | 0 55 | 10 | - | μS |
| Read Data to Data Clock Delay Time 2 | tRDD2 | 0.55 | 1.0 | _ | μS |
| Read Data Pulse Width, High | tRDH | _ | 10 | _ | μS |
| Read Data Pulse Width, Low | tRDL | - | 10 | - | μS |
| Index Pulse Width, High | PWIDX | 10 | - | | μS |
| Transfer Request Release Time | tTR. | <u> </u> | | 450 | ns |
| Interrupt Request Release Time | tIR | | - | 12 | μS |
| Bus Direction Delay Time | †DBD | | | 330 | ns |
| Write Data Pulse Width, High (f _C =1 0 MHz) | PWWD | | 10 | _ | μS |
| Write Data Cycle Time (f _C = 1 0 MHz) | tcvcWD | | 20 | | μS |
| Step Pulse Width, High (f _C =1 0 MHz) | PWSTP | | 32 | _ | μS |
| Step Cycle Time* (f _C =1 0 MHz) | tcycSTP | 10 | | 15 | ms |
| Write Gate to Write Data Delay (SSW, SWD, MSW) | tGD1 | 0.7 | 10 | 13 | μS |
| Write Gate Hold Time | ^t GH | 0 | _ | 0.3 | μS |
| Write Gate to Write Data Delay (FFW) | tGD2 | 02 | | 20 | μS |
| CLK to IRQ Delay | tIRQC | | - | 1 2 | μS |
| CLK TO ISR0-3 Delay | tISRD | T - | - | 07 | μS |
| Index Pulse to STRB Bit 3 Delay | tIRQI | _ | - | 18 | μS |
| Index Pulse to IRQ Delay | tSTRB3 | _ | _ | 10 | μS |
| Data Clock to Transfer Request Delay | tDTx | 400 | _ | 700 | ns |
| Signal Rise and Fall Times | t _r , t _f | | - | 25 | ns |

^{*}Step (STP) cycle time is programmable

BUS TIMING CHARACTERISTICS (See Notes 1 and 2)

| ldent. Number | Characteristic | Symbol | Min | Max | Unit |
|------------------|---|---------------------------------|-----|------|------|
| 1 | Cycle Time | t _{cyc} | 10 | 10 | μS |
| 2 | Pulse Width, E Low | PWEL | 430 | 9500 | ns |
| 3 | Pulse Width, E High | PWEH | 450 | 9500 | ns |
| 4 | Clock Rise and Fall Time | t _r , t _f | _ | 25 | ns |
| 9 | Non-Muxed Address Hold Time | tAH | 10 | _ | ns |
| 13 | Address Setup Time Before E | tAS | 80 | | ns |
| 14 | Chip-Select Setup Time Before E | tCS | 80 | _ | ns |
| 15 | Chip-Select Hold Time | tCSH | 10 | | ns |
| 18 | Peripheral Read Data Hold Time Provided | tDHR | 20 | 100 | ns |
| 21 | Write Data Hold Time | tDHW | 10 | _ | ns |
| 30 | Peripheral Output Data Delay Time | ^t DDR | _ | 290 | ns |
| 31 | Peripheral Input Data Setup Time | tDSW | 165 | _ | ns |

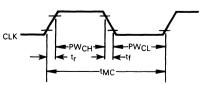
FIGURE 4 - BUS TIMING CHARACTERISTICS (See Notes 1 and 2)



Notes

- 1 Voltage levels shown are V_L \leq 0 4 V, V_H \geq 2 4 V, unless otherwise specified 2 Measurement points shown are 0 8 V and 2 0 V, unless otherwise specified

FIGURE 5 - MASTER CLOCK (CLK)



Note. Timing measurements are referenced to and from a low voltage of 0 8 volts and a high voltage of 20 volts, unless otherwise noted

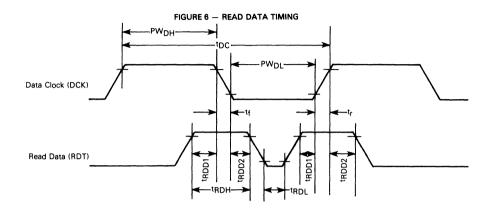
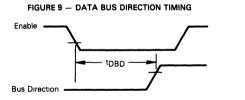


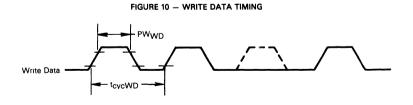
FIGURE 7 — INDEX TIMING

FIGURE 8 — IRQ RELEASE TIME

Enable

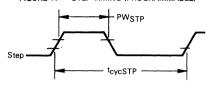
Interrupt Request





Note Timing measurements are referenced to and from a low voltage of 0.8 volts and a high voltage of 2.0 volts, unless otherwise noted.

FIGURE 11 - STEP TIMING (PROGRAMMABLE)



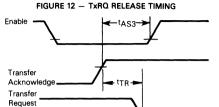


FIGURE 13 — DELAY TIME FROM DATA CLOCK TO TRANSFER REQUEST (tDTx)

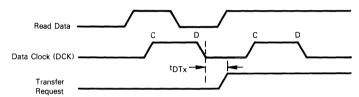


FIGURE 14 - WRITE DATA versus WRITE GATE TIMING

 $a-SSW, SWD \ and \ MSW \ commands \ (Single \ Sector \ Write, \ Single \ Sector \ Write \ with \ Deleted \ Address \ Mark, \ and \ Multiple \ Sector \ Write)$

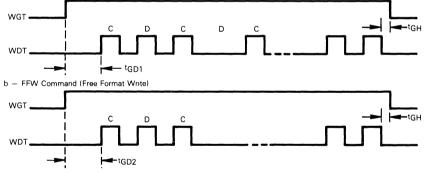
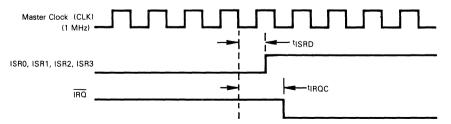
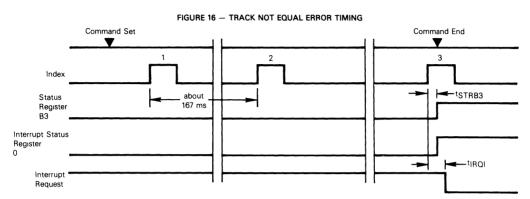


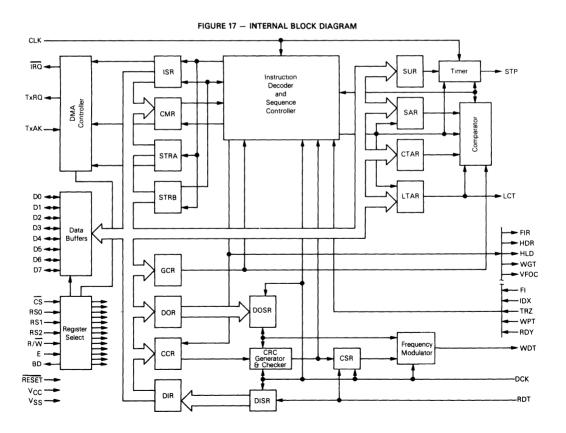
FIGURE 15 - INTERRUPT STATUS REGISTER AND INTERRUPT REQUEST TIMING



Note Timing measurements are referenced to and from a low voltage of 0.8 volts and a high voltage of 2.0 volts, unless otherwise noted



Note Timing measurements are referenced to and from a low voltage of 0.8 volts and a high voltage of 2.0 volts, unless otherwise noted



GENERAL DESCRIPTION

The MC6843 FDC is a single-density controller which is IBM compatible. Data from the drive is clocked into the FDC by an external phase lock loop oscillator Internal synchronization to the data stream is handled automatically A 1 MHz clock is used as a timing signal for the internal functions of the FDC, such as head load and step, as well as shifting data senally to the drive Status bits are provided to indicate various error conditions and status of the drive DMA or polled I/O modes are available

Register Section

The register section consists of twelve user-accessible registers used for controlling a floppy disk drive. All twelve are connected by the internal data bus to allow the processor access to them.

Data Output Register (DOR) — The DOR is an 8-bit register which holds the data to be written onto the disk. The information is stored here by the bus interface

Data Input Register (DIR) — The data words read from the disk are stored in the 8-bit DIR until read by the bus interface

Current-Track Address Register (CTAR) — CTAR is a 7-bit register containing the address of the track over which the R/W head is currently positioned

Command Register (CMR) — The macro commands are written to the 8-bit CMR to begin their execution

Interrupt Status Register (ISR) — The four bits of the ISR represent the four conditions that can cause an interrupt to occur.

Set-Up Register (SUR) — Variable Seek and Settling times are programmed by the SUR Four bits are used to program the track-to-track seek time and four bits are used to program the head settling time for the floppy disk drive used with the FDC

Status Register A (STRA) — The eight bits of STRA are used to indicate the state of the floppy disk interface

Sector Address Register (SAR) — SAR contains the 5-bit sector address associated with the current data transfer.

Status Register B (STRB) — The eight error flags of STRB are used to signify error conditions detected by the FDC or generated by the floppy disk drive.

General Count Register (GCR) — The seven bits of GCR contain the destination track address when a SEK (seek) macro command is being executed. If a multi-sector Read or Write macro command is being executed, GCR contains the number of sectors to be read or written

CRC Control Register (CCR) — The two bits of the CCR are used to enable the CRC and shift the CRC for the Free-Format Commands.

Logical-Track Address Register (LTAR) — The 7-bit track address used for read and write operations is stored in the LTAR by the bus interface.

Serializing Section

The serializing section handles the serial-to-parallel and parallel-to-serial conversions for Read/Write operations, as well as CRC generation/checking and the generation/detection of the clock pattern. The Data Output Shift Register (DOSR), Data Input Shift Register (DISR), CRC Generator/Checker, and Clock Shift Register (CSR) comprise the serializing section of the FDC.

Bus Interface

The Bus Interface section provides the timing and control logic that allows the FDC to operate with the M6800 bus, and is comprised of the Data Buffers, DMA Control, and the Register Select circuitry

Control

The internal timing and control signals which sequence the FDC are derived from the macro instructions by the control section.

PIN DESCRIPTION

POWER PINS

Vcc: Input

+5 volt (±5%) power input.

VSS: Input

Power Supply Ground

BUS PINS

Reset Input — The \overline{RESET} input is used to initialize the FDC. When \overline{RESET} becomes Low, the state of the outputs is defined by the table below

| Output | State of Output | Output | State of Output |
|--------|-----------------|--------|-----------------|
| FIR | Low | HLD | Low |
| WGT | Low | TxRQ | Low |
| HDR | Low | IRQ | High |
| STP | Low | WDT | Low |

Registers which are affected by RESET are shown in Table 7

Interrupt Request (\overline{IRQ}) Output — The \overline{IRQ} line is an opendrain output that becomes a low level when the FDC requests an interrupt Interrupt requests are controlled by the interrupt enables in CMR (Command Register) with the function causing the interrupt shown in ISR (Interrupt Status Register)

Data Bus 0-Data Bus 7 (D0-D7) Bidirectional — The eight bidirectional data lines allow the transfer of data between the FDC and the controlling system. The output buffers are three-state drivers that are enabled when the FDC is transferring data to the data bus

Enable (E) Input — The E input to the FDC causes data transfers to occur between the FDC and the system controlling the FDC (MC6800 MPU, DMA Controller, etc.). E must be a logic '1' (high level) for any transfer to be enabled on D0-D7. The E input is normally connected to system $\phi 2$

Chip-Select (CS) Input — The \overline{CS} input, in conjunction with the E input, is used to enable data transfers on D0-D7 E must be a high level and \overline{CS} must be a low level to enable the transfer. The TxAK input being a high level (logic '1') performs a function similar to \overline{CS} being a low level

Read/Write (R/W) Input — The R/W input is issued by the system controlling the FDC (MC6800 MPU, DMA Controller, etc.) to signify if a read or write operation is to be performed on the FDC When TxAK is a low level, R/W is used in conjunction with $\overline{\text{CS}}$ and RS0-RS2 to determine which register is accessed by the bus as shown in Table 1. When TxAK is a high level, R/W is used to select either the DOR or DIR to the data bus (see description of TxAK input).

Register Select 0-Register Select 2 (RS0-RS2) Input - RS0-RS2, in conjunction with the R/\overline{W} input, are used to select one of the user accessible registers in the FDC as shown in Table 1

TABLE 1 — ADDRESS CODES FOR USER ACCESSIBLE REGISTERS

| TxAK | RS2 | RS1 | RS0 | R/W | Registers |
|------|-----|-----|-----|-----|--|
| 0 | 0 | 0 | 0 | 0 | DOR (Data Out Register) |
| Ů | | U | | 1 | DIR (Data In Register) |
| 0 | 0 | 0 | 1 | 1/0 | CTAR (Current Track Address Register) |
| 0 | 0 | 1 | 0 | 0 | CMR (Command Register) |
| 0 | U | ' | U | 1 | ISR (Interrupt Status Register) |
| 0 | 0 | 1 | 1 | 0 | SUR (Set Up Register) |
| | 0 | _ ' | ' | 1 | STRA (Status Register A) |
| | | | | 0 | SAR (Sector Address |
| 0 | 1 | 0 | 0 | | Register) |
| | | | | 1 | STRB (Status Register B) |
| 0 | 1 | 0 | 1 | 0 | GCR (General Count Register) |
| 0 | 1 | 1 | 0 | 0 | CCR (CRC Control Register) |
| 0 | 1 | 1 | 1 | 0 | LTAR (Logical Track Address Register) |

Transfer Request (TxRQ) Output — TxRQ is used in the DMA mode to request a data transfer by the DMAC TxRQ is a high level if the FDC is in the DMA mode (CMR bit 5 is set) when a data transfer request occurs (STRA bit 1 is set). It is reset to a low level (logic '0') when TxAK becomes a high level (logic '1') Data transfer errors will occur if TxAK does not reset TxRQ before the next data transfer is required

Transfer Acknowledge (TxAK) Input — TxAK is generated by the system controlling the FDC (MC6800 MPU, DMA Controller, etc.) and is a response to a TxRQ issued by the FDC. A high level (logic '1') on TxAK causes the FDC to select the state of RS0-RS2 and $\overline{\text{CS}}$ causing the FDC to select the DOR (Data Output Register) or DIR (Data Input Register) to the data bus (D0-D7) as shown in Table 2

TABLE 2 — REGISTER SELECTION FOR DMA TRANSFERS

| TxAK | RS0-RS2 | cs | R/W | Register Selected |
|------|---------|---------------|-----|----------------------|
| 1 | X | X | 1 | DOR |
| 1 | X | X | 0 | DIR |

This mode of operation is normally used for DMA (Direct Memory Access) transfer with the FDC

When TxAK is a low level the registers are selected by CS, R/W and RS0-RS2 as shown in Table 1.

Bus Direction (BD) Output — The BD output is provided to control bidirectional buffers on the data bus (D0-D7) as shown in Figure 1. Its polarity is shown by Table 3.

TABLE 3 - BUS DIRECTION (BD) STATES

| TxAK | cs | BD |
|------|----|-----|
| 1 | X | R/W |
| 0 | 1 | 0 |
| 0 | 0 | R/W |

(Operation of BD, as defined by this chart, allows the FDC to function with the DMA Controller MC6844)

I/O AND CONTROL PINS

Master Clock (CLK) Input — The CLK input is used to generate various timing sequences internal to the FDC. The head settling and seek time, as well as the data and data clock timing, are generated from the CLK input signal

Head Load (HLD) Output — HLD is used to notify the disk drive that the R/W head should be loaded (placed in contact with the media) When the FDC is ready for the head to load, HLD is a high level (logic '1') A low level (logic '0') on HLD indicates the head should be unloaded

Step (STP) Output — The STP output, in conjunction with HDR, is used to control head movement A $32~\mu s$ wide positive (logic '1') pulse is generated on STP, to move the R/W head one track in the direction defined by the HDR output. The period of the STP signal is programmable by the SUR (Set-Up Register). The number of pulses generated on STP is the difference between the contents of the CTAR (Current Track Address Register) and the GCR (General Count Register) which contains the track address to which the head is to be moved

Head Direction (HDR) Output — The HDR signal controls the direction of head movement. A high level (logic '1') signifies the head should step to the inside (toward the hub) of the disk. A low level (logic '0') indicates the direction of head movement should be to the outside of the disk.

Low-Current Track (LCT) Output — The LCT signal is used to control the level of write current used by the disk drive. LCT is a low level (logic '0') when the write head is positioneo over tracks 0-43 if it is over tracks 44-76, LCT is a high level (logic '1') LCT is determined from the contents of the Current Track Address Register (CTAR)

Write Gate (WGT) Output - When a write operation is being performed, WGT is a logic '1' (high level). For a read operation, WGT is a low level (logic '0')

File-Inoperable Reset (FIR) Output - FIR is an output from the FDC to the floppy disk drive to reset it from an inoperable status If the FI input is a '1', a 1 us pulse is generated on the FIR output whenever Status Register B is read

File Inoperable (FI) Input - FI is an input to the FDC from the drive. A high level indicates the drive is in an inoperable state. Its current state can be examined by reading bit 5 of Status Register B (STRB)

Track Zero (TRZ) Input - The TRZ input is reflected by bit 3 of STRA (Status Register A) The TRZ input must be a high level (logic '1') when the R/W head of the drive is positioned over track zero. A logic '1' on this input inhibits step pulses during a Seek Track Zero command

Index (IDX) Input - The index input is received from the floppy disk drive and is used to sense the index hold in the disk media. The IDX signal is used to initialize the internal FDC timing. The state of the IDX input is reflected by bit 6 of Status Register A (STRA) A high level (logic '1') is to indicate the index hole is under the index sensor. The index input is used to count the number of disk revolutions while searching for the address ID field (see description of STRB

Ready (RDY) Input - The ready input is received from the disk drive and can be read as bit 2 of STRA (Status Register A) A high level (logic '1') indicates the drive is ready and allows the FDC to operate the drive

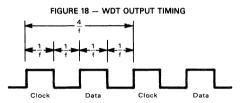
Write Protect (WPT) Input - WPT is an input indicating when the media is Write Protected. A high level during an FDC write operation results in a Write Error (STRB bit 6) but the FDC continues to perform the write function. The state of the WPT input can be read by examining bit 4 of the Status Register A (STRA).

DATA PINS

Data Clock (DCK) Input - Data from the drive is clocked into the FDC on both positive and negative edges of the DCK input. This signal is generated from the Read Recovery Cir-

Read-Data (RDT) Input - RDT is the serial data input from the Read Recovery Circuit. The data stream includes both the clock and the data bits and must be presynchronized to the Data Clock (DCK).

Write-Data (WDT) Output - WDT is the double frequency modulated data output from the FDC. The time between clock bits is 4/f where f is the frequency of the CLK input The pulse width for both clock and data is 1/f (see Figure 18) For the normal CLK frequency of 1 MHz the write period is 4 us, the clock pulse width is 1 us and the data pulse width is 1 us Figure 18 shows the relationship between the WDT output and the frequency of the CLK inputs



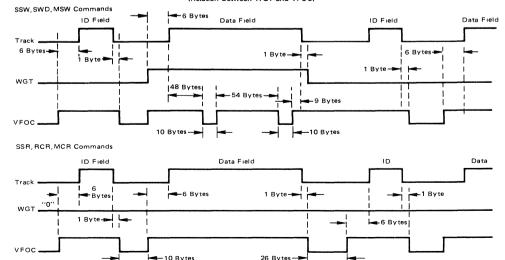
f = Frequency of the CLK Input To insure IBM3740 compatibility the clock frequency must be 1 MHz

Variable-Frequency Oscillator Control (VFOC) Output -VFOC is used as a sync signal during system diagnostics Waveforms are shown in Figure 19

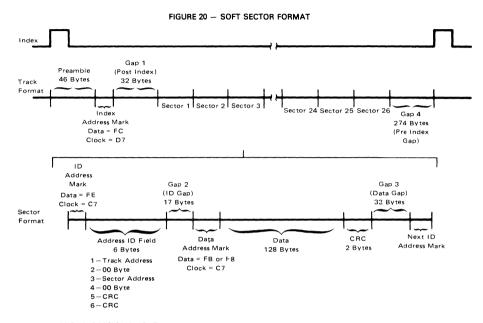
FORMAT

The format used by the MC6843, shown in Figure 20, is compatible with the soft sector format of the IBM 3740.

FIGURE 19 - VARIABLE FREQUENCY OSCILLATOR CONTROL WAVEFORM (Relation Between WGT and VFOC)



-10 Bytes



MACRO COMMAND SET

The macro command set shown in Table 4 is discussed in the following paragraphs

Seek Track Zero (STZ)

The STZ command causes the R/W head to be released from the surface of the disk (HLD is reset) and positioned above track 00. The FDC issues step pulses on the STP output until the TRZ input becomes a high level or until 83 pulses have been sent to the drive. When the TRZ input becomes high, the step pulses are inhibited on the STP output but the FDC remains busy until all 83 have been generated internally.

If the TRZ input remains low (logic '0') after all 83 pulses have been generated, the Seek Error flag (STRB bit 4) is set.

After all 83 pulses have been generated, the head is loaded (HLD becomes a '1') After the settling time specified in the

SUR has expired, the Settling Time Complete flag is set (ISR bit 1), Busy (STRA-7) is reset, and CTAR and GCR are cleared The head remains in contact with the disk. A command such as RCR (Read CRC) may be issued following a STZ if the head must be released.

Seek (SEK)

The SEK command is used to position the R/W head over the track on which a Read/Write operation is to be performed. The contents of the GCR are taken as the destination address and the contents of the CTAR is the source address, therefore, the number of pulses (N) on the STP output are given by.

$$N = |(CTAR) - (GCR)|$$

HDR is a '1' for (GCR) > (CTAR) otherwise it is a '0' When a SEK command is issued, Busy is set, the head is raised from the disk, HDR is set, and N number of pulses ap-

TABLE 4 - MACRO COMMAND SET

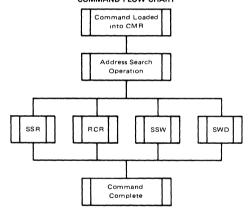
| | CMR Bits | | | | | Hex | |
|----|----------|---|-------|-------|-------|-------|------|
| | | | Bit 3 | Bit 2 | Bit 1 | Bit 0 | Code |
| 1 | STZ | Seek Track Zero | 0 | 0 | 1 | 0 | 2 |
| 2 | SEK | Seek | 0 | 0 | 1 | 1 | 3 |
| 3 | SSR | Single Sector Read | 0 | 1 | 0 | 0 | 4 |
| 4 | SSW | Single Sector Write | 0 | 1 | 0 | 1 | 5 |
| 5 | RCR | Read CRC | 0 | 1 | 1 | 0 | 6 |
| 6 | SWD | Single Sector Write with Delete Data Mark | 0 | 1 | 1 | 1 | 7 |
| 7 | MSW | Multi Sector Write | 1 | 1 | 0 | 1 | D |
| 8 | MSR | Multi Sector Read | 1 | 1 | 0 | 0 | С |
| 9 | FFW | Free Format Write | 1 | 0 | 1 | 1 | В |
| 10 | FFR | Free Format Read | 1 | 0 | 1 | 0 | Α |

number of pulses appear on the STP output. After the last step pulse is used, the head is placed in contact with the disk. Once the head settling time has expired, the Settling Time complete flag (ISR bit 1) is set, Busy is reset, and the contents of the GCR are transferred to the CTAR.

SINGLE-SECTOR READ/WRITE COMMANDS

The single-sector Read/Write commands (SSR, RCR, SSW, and SWD) are used to Read/Write data from a single 128 byte sector on the disk. As shown in Figure 21 these types of instructions can be divided into two sections. The first section, which is common to all instructions, is the address search operation, while the second section is unique to the requirements of each instruction.

FIGURE 21 — BASIC SINGLE SECTOR COMMAND FLOW CHART



Address Search Operation

The flow chart of Figure 22 shows the operation of the address search

Single-Sector Read (SSR)

The single-sector read command follows the address search procedure as defined in the previous flowchart. If the search is successful, status sense request is set and the operation continues as described by the flowchart of Figure 23

Read CRC (RCR)

The RCR command is used to verify that correct data was written on a disk. The operation is the same as for the SSR command with the exception that the data-transfer request (STRA bit 0) is not set. The SSR interrupt can be disabled by using the DMA mode

Single-Sector Write (SSW)

Single-sector write is used to write 128 bytes of data on the disk. After the command is issued, the address search is performed. The remainder of the instruction's operation is shown in Figure 24

Single-Sector Write with Delete-Data Mark (SWD)

The operational flow of SWD is exactly like that of SSW For SWD, the data pattern of the Data-Address Mark becomes F8 instead of FB. The clock pattern remains C7

Multi-Sector Commands (MSR/MSW)

MSR is used for sequential reading of two or more sectors. If S sectors are to be read, S1 must be written into the GCR before the command is issued.

The basic operation for the MSR and MSW is the same as that for the SSR and SSW repsectively. The basic operation begins with an address search operation, which is followed by a single-sector read or write operation. This completes the operation on the first sector. The SAR is incremented, the GCR is decremented, and if no overflow is detected from the GCR (i.e., GCR becomes negative) the sequence is repeated until S number of sectors are read or written.

The completion of an MSR or MSW is like that of an SSR or SSW command. First MCC is set, after the settling time has expired, Busy is reset, and the head is released.

If a delete-data mark is detected during an MSR command, STRA bit 1 (Delete-Data Mark Detected) remains set throughout the commands operation

When a multi-sector instruction is issued, the sum of the SAR and GCR must be less than 27 If SAR+GCR>26, an address error (STRB bit 3 set) will occur after the contents of SAR becomes greater than 26

Free-Format Write (FFW)

The FFW has two modes of operation which are selected by FWF (Free-Format Write Flag) which is data bit 4 of the CMR

When the FWF = '0', the data bits of the DOR are written directly to the disk without first writing the preamble, address mark, etc. The contents of the DOR are FM modulated with a clock pattern of all ones

If FWF='1' the odd bits of the DOR are used as clock bits and even bits are used for data bits. In this mode, the DOSR clock is twice a normal write operation and one byte of DOR is one nibble (four bits of data) on the disk

The two modes of the FFW command allow formatting a disk with either the IBM 3470 format or a user defined format.

After the FFW command is loaded into the CMR, WGT becomes a high level, the contents of DOR are transferred to the DOSR, data transfer request (STRA bit 0) is set, and the serial bit pattern is shifted out on the WDT line. Therefore, DOR must be loaded before the FFW command is issued Data from the DOR is continually transferred to the DOSR and shifted out on WDT until the CMR has been written with an all zero pattern. When CMR becomes zero, WGT becomes a low level, but MCC is not set and the R/W head is left in contact with the disk.

Free-Format Read (FFR)

FFR is used to input all data (including Address Marks) from a disk. Once the FFR command is set into the CMR, the head is loaded and after the settling time has expired the serial data from the FDC is brought into the DISR. After 8 bits have accumulated, it is transferred to the DIR and Data-Transfer Request (STRA bit 0) is set

FIGURE 22 - OPERATIONAL FLOW OF THE ADDRESS SEARCH SEQUENCE

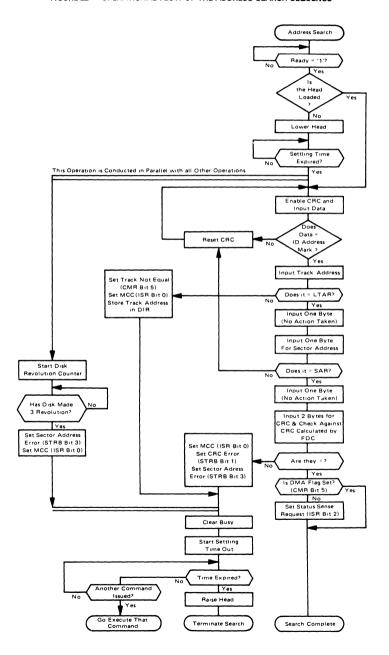
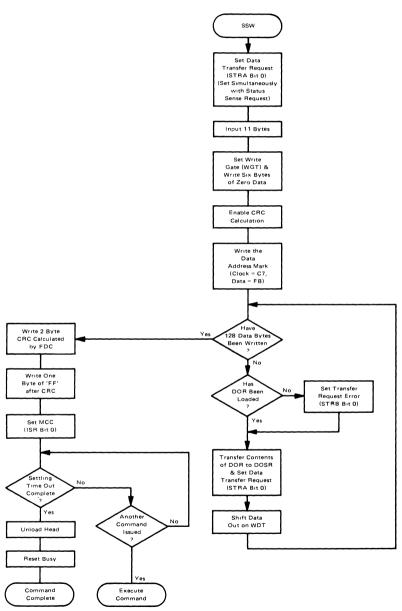


FIGURE 23 - OPERATIONAL FLOW OF THE SSR COMMAND SSR Start Byte Count Set Data Address Mark Undetected Byte Coun (STRB Bit 2) Set MCC Greater than (ISR Bit 0) No Enable CRC & Input 1 Byte Reset CRC & it a Data Increment Address Mark Byte Count Yes Set Delete Data Mark Detected Delete Data (STRB Bit 1) ž Input One Byte of Data Set Data Last Data Transfer Error (STRB Bit 0) Read From DIR ? Yes Transfer Request & Transfer Data From DISR to DIX Read 128 Bytes Yes Input 2 Bytes for CRC Set CRC Error it = CRC (STRB Bit 1) Calculated by Set MCC FDC ? (ISR Bit 0) Set MCC (ISR Bit 0) Busy Reset Start Settling Time-Out No Expired ? Yes Another Command Raise Head No Issued Yes Reset Busy Command Complete Execute Command

FIGURE 24 - OPERATIONAL FLOW OF THE SSW COMMAND



This operation continues until a zero pattern is stored in the CMR, terminating the FFR command. As in the case of the FFW command, MCC is not set and the head remains in contact with the disk

The first data that enters the DISR is not necessarily the first bit of a data word since the head may be lowered at any place on the disk. To prevent the FDC from remaining unsynchronized to the data, the FFR command will synchronize to either an ID address mark (FE) or a Data-Address Mark (FB or F8).

REGISTER DEFINITIONS

DATA OUTPUT REGISTER (DOR)

Hex address 0, write only

| Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 |
|-------|----------|----------|----------|----------|---------|----------|-------|
| | 8 Bits o | f Data U | Jsed for | a Disk \ | Write O | peration | |

When one of the four write macro commands (SSW, SWD, MSW, and FFW) is executed, the information contained in the DOR is loaded into the DOSR, and is shifted out on the WDT line using a double frequency (FM) format

DATA INPUT REGISTER (DIR)

Hex address 0, read only

| ſ | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | | |
|---|---|-------|-------|-------|-------|-------|-------|-------|--|--|
| ſ | 8 Bits of Data Used for a Disk Read Operation | | | | | | | | | |

One of the three read macro commands (SSR, MSR, FFR) executed, will cause the information on the RDT input to be clocked into the DISR. When eight clock pulses have occurred, the eight bits of information in the DISR are transferred to the DIR where it can be read by the bus interface

CURRENT TRACK ADDRESS (CTAR)

Hex address 1, read/write

| Bit 7 | Bit 6 Bit 5 Bit 4 Bit 3 Bit 2 Bit 1 Bit 0 | | | | | | | |
|-------------|--|--|--|--|--|--|--|--|
| Not Used | 7 Bit Track Address of Current Head Position | | | | | | | |

The address of the track over which the R/W head is currently positioned is contained in the CTAR. At the end of a SEK command, the contents of the GCR are transferred to the CTAR. CTAR is cleared at the completion of a STZ command. CTAR is a read/write register so that the head position can be updated when several drives are connected to one FDC. Bit 7 is read as a '0'.

COMMAND REGISTER (CMR)

Hex address 2, write only

| Function ISR3 DMA Interrupt Interrupt FWF Macro Command | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3* | Bit 2* | Bit 1* | Bit 0* |
|---|-----------|-----------|-------------|-------|--------|---------|--------|--------|
| Mask Mask Flag | Interrupt | Interrupt | DMA Flag | FWF | N | 1acro C | ommai | nd |

^{*}Bits 0-4 are clared by RESET.

The commands that control the FDC are loaded into the lower four bits of the CMR. Information that controls the

data transfer mode and interrupt conditions are loaded into bits 4 through 7

Bit 0-Bit 3: Macro Command

The Macro Command to be executed by the FDC is written to bits 0-3

Bit 4: Free-Format Write Flag (FWF)

If a Free-Format Write command is issued, the state of bit 4 of the CMR determines what clock source will be used The FWF is defined in the FFW (Free-Format Write) command explanation

Bit 5: DMA Flag

If bit 5 is a '1' the FDC is in the DMA mode Bit 5 being a '1' inhibits setting of Status Sense Request (ISR bit 2) thereby preventing its associated interrupt. A logic '1' DMA flag also enables the TxRQ output allowing it to request DMA transfers when the Data Transfer Request flag (STRA bit 0) is set

A logic '0' DMA flag indicates the program controlled I/O (PC I/O) mode is to be used

Bit 6: ISR3 Mask

CMR bit 6 (ISR3 Mask) is used to control the operation of ISR bit 3. A logic '1' in CMR bit 6 inhibits ISR bit 3 from being set when STRB becomes non-zero. If CMR bit 6 (ISR3 Mask) is a '0' the ISR bit 3 will be set if any bit in STRB becomes set. The setting of ISR bit 3 will cause an interrupt if CMR bit 7 is a '0'.

Bit 7: Function Interrupt Mask

When CMR bit 7 is a logic '1' all interrupts are inhibited except Status Sense Request (ISR bit 2) which can only be inhibited by the DMA flag (CMR bit 5). A logic '0' in CMR bit 7 anables interrupts from ISR0 (Macro Command Complete) and ISR1 (Settling Time Complete), and if the ISR3 Mask is '0', from ISR3

TABLE 5

| | Command Register Masks That Affect Interrupts | | | | |
|--|--|---------------------|--------------------|--|--|
| Interrupt Status Register (Bits Causing Interrupts) | CMR7 (Function Interrupt Mask) | CMR6 (ISR3 Mask) | CMR5 (DMA Flag) | | |
| ISR0 (Macro Command Complete) | м | × | × | | |
| ISR1 (Settling Time Complete) | М | X | × | | |
| ISR2 (Status Sense Request) | × | х | М | | |
| ISR3 (STRB Conditions) | М | М | × | | |

X = No effect

M = Bits that are used as masks

INTERRUPT STATUS REGISTER (ISR)

Hex address 2, read only

| Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 |
|---------------------------|-------|-------|-------|-----------------------------|-------------------------------|------------------------|-------|
| Not Used (Read as '0') | | | STRB* | Status* Sense Request | Settling* Time Complete | Macro* Com- mand | |

^{*}Cleared by RESET

Bit 0: Macro Command Complete

When an SSR, RCR, SSW, SWD, MSR or MSW Macro Command has completed execution, bit 0 bcomes set (logic '1') If the function interrupts are enabled (bit 7 of CMR is a logic '0'), the conclusion of a Macro command's execution will cause an interrupt

Bit 1: Settling Time Complete

Settling time complete is set on SEK and STZ commands to indicate the head has been loaded and the settling time specified in SUR has expired. Since MCC is not set for the SEK or STZ command, settling time complete can be used as an interrupt to signify the SEK or STZ command has finished. Settling Time Complete is not set for any of the R/W commands.

Bit 2: Status Sense Request

For an SSR, SSW, SWD, MSR, or MSW Command, Status Sense Request indicates that the specified address ID field has been detected and verified by a CRC check. This is used as an early indication that data transfers will occur after 18 more byte times. For MSR and MSW commands, it is set for each sector.

In the PC I/O mode, an interrupt occurs when Status Sense Request becomes a logic '1' regardless of the state of the CMR interrupt mask. In the DMA mode, (DMA flag of CMR is set) Status Sense Request is unchanged and does not generate an interrupt when the address ID field has been verified.

Bit 3: STRB

STRB is an 'OR' of all of the bits of Status Register B and is disabled by the STRB interrupt mask in the CMR (CMR bit 6). The equation:

STRB = CMR6•(STRB + STRB1 + STRB2 + STRB3 + STRB4 + STRB5 + STRB6 + STRB7)

describes the operation of Bit 3 of the ISR

ISRO, ISR1, and ISR2 are cleared when the Interrupt Status Register is read, but ISR3 is cleared only after Status Register B has been read.

SET-UP REGISTER (SUR)

Hex address 3, write only

| Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 |
|-------|--------------------|-------|-------|-------|-------|-------|-------|
| Track | Head Settling Time | | | | | | |

The SUR is not affected by a reset operation; therefore, once it is initialized, the information remains until power is removed from the FDC

Bit 0-Bit 3: Head Settling Time

The head settling time is used to generate a delay after the head is placed in contact with the disk. This allows the head

to stop bouncing before any operations are performed. The delay is programmed by bits 0-3 and is specified by the equation.

Delay =
$$\frac{4096}{4} \cdot B$$

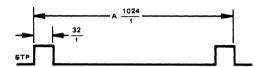
B = Number contained in bits 0-3 of SUR f = Frequency of CLK input

For IBM 3740 compatibility f = 1 MHz and the timing range is 4 096 ms for a '0001' to 61 44 ms for a '1111'. A '0000' code prevents Settling Time complete from being set and the FDC must be Reset

Bit 4-Bit 7: Track-to-Track Seek Time

The frequency of STP is determined by bit 4-bit 7 of SUR as shown below. If the track-to-track seek time is 0 the period of STP is 64/f

A = Number specified in bits 4-7 of SUR f = Frequency of clock input



- A = Number specified in bits 4-7 of SUR.
- f = Frequency of clock input.

For IBM compatible operation, f is 1 MHz. This results in an STP pulse width of 32 μ s and an STP interval of 1.024 ins for 0001 in bits 7-4 to 15.36 ms for 1111.

STATUS REGISTER A (STRA)

Hex address 3, read only

| Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 |
|-------|-------|------------------------|-------|---------------|----------------|-------------------------------------|------------------------------|
| Busy | Index | Track* Not Equal | | Track Zero | Drive Ready | Delete* Data Mark Detected | Data* Transfer Request |

^{*}Cleared by RESET

Bit 0: Data Transfer Request

For a write operation (SSW, SWD, MSW, FFW) the transfer request bit indicates that the DOR is ready to accept the next data word to be written on the disk. If data is not written into the DOR before the last data bit in the DOSR is shifted out to the WDT line, the data transfer error bit (bit 0 of STRB) will be set. After a write command has been issued, the first transfer request occurs simultaneously with the Status Sense Request. For a write operation, transfer request is reset after the DOR has been written from the data bus.

During a read operation (SSR, MSR, FFR) the transfer request bit signifies data from the DISR has been transferred to the DIR. The DIR must be read before the DISR is full again or the data transfer error bit (bit 0 of STRB) will be set For read operations, transfer request is reset by a read of the DIR

Bit 1: Delete Data Mark Detected

A Single-Sector Read operation that detects a delete data code (F8), instead of a general code (FB) as a Data Address Mark, will set the Delete Data Mark Detected bit For the MSR command, bit 1 is set the first time an 'F8' code is found and remains set throughout the execution of the command. Bit 1 is reset whenever an SSR, SSW, SWD, MSR, MSW, or RCR command is issued

Bit 2: Drive Ready

The Drive Ready bit indicates the state of the Ready input from the floppy disk drive. If a command is issued with Ready at logic '0', its execution will be inhibited until Ready becomes a logic '1'. If ready becomes a '0' during the execution of a command the Hard Error Flag (STRB bit 7) is set.

Bit 3: Track Zero

The state of the Track Zero input from the floppy disk drive is reflected in this bit of STRA. A logic '1' on the Track Zero input inhibits step pulses during an STZ command.

Bit 4: Write Protect

The Write Protect input from the floppy disk drive is reflected by bit 4 of STRA A high level (logic '1') on the WPT input during the execution of any write command results in a write error (bit 6 of STRB set)

Bit 5: Track Not Equal

If the track address read from the address ID field does not coincide with the address in the LTAR, the Track Not Equal bit is set Track Not Equal applies to all non-free format read/write commands, and is reset after a non-free format read/write command is issued

Bit 6: Index

The state of the index input appears in bit 6 of STRA. The index input is used to count the number of disk revolutions while the FDC is looking for the address ID field (see operation of STRB bit 3) during the address search phase of a nonfree format read/write command.

Bit 7: Busy

When Busy is a logic '1', the FDC is executing a command and no new commands can be issued

SECTOR ADDRESS REGISTER (SAR)

Hex address 4, write only

| [| Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 |
|---|-------|----------|-------|-------|---------|----------|--------|-------|
| ſ | ١ | Not Used | j | | 5 Bit S | Sector A | ddress | |

Before a data transfer macro command (SSW, SWD, SSR, RCR, MSW, MSR) is issued, the address of the sector on which the operation is to be performed must be written into the SAR. The address in the sector address byte of an Address ID field of the disk is compared with the contents of the SAR. During an MSW or MSR command, the SAR is incremented after each sector is read or written. When execution is complete, the SAR contains the address of the last sector on which an operation was performed plus one. At the completion of an STZ or SEK command, SAR is cleared.

STATUS REGISTER B (STRB)

Hex address 4, read only

| | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 |
|---|-------|--------|--------|-------|---------|--------|-------|--------|
| | | | | | Sector* | Data* | | Data* |
| | Hard* | Write* | File | Seek* | Address | Mark | CRC* | Trans- |
| | Error | Error | Inop- | Error | Unde- | Unde- | Error | fer |
| ĺ | | | erable | | tected | tected | , | Error |

^{*}Cleared by RESET

The bits of the STRB represent possible error conditions that may occur during execution of macro commands Whenever STRB is reset, ISR bit 3 is also reset

Bit 0: Data Transfer Error

Data Transfer indicates an underflow or overflow of data. If a Write operation is being performed, it signifies that data was not presented to the DOR before the DOSR became empty. In this case, the current contents of the DOR are transferred to the DOSR and the write operation continues. The data transfer error remains set until data is written into the DOR. The operation of the CRC is unchanged.

For read commands, a data transfer error indicates that data in the DIR was not read before the next data word from the disk was transferred to the DIR. The read operation continues until sufficient data has been read from the disk to satisfy the requirements of the command (128 bytes for SSR). The error indication remains set until STRB is read, and the transfer request remains set until data is read from the DIR

Bit 1: CRC Error

A CRC error occurs when the CRC read from the disk does not match that calculated by the FDC on the data it reads from the disk. A CRC error can occur in three different situations; checking the address ID field, checking the data field, and checking the FFR data. (See operation of CCR)

If the CRC error occurs during the check of an address ID field, Sector Address Undetected (STRB bit 3) will also be indicated (see Table 6) A CRC error of a data field is indicated by a CRC error and no sector address error

Bit 2: Data Mark Undetected

If a valid mark is not detected in the data block of a sector, it is indicated by a Data Mark Undetected error Data Mark Undetected is reset after a non-free format Read/Write command is issued.

Bit 3: Sector Address Undetected

The sector address bit can be set on two conditions, not finding the sector address and a CRC error on an address ID field.

If the disk makes three revolutions during an address search operation and the sector address specified in the sector address register is not found in any of the address ID fields, a sector address undetected condition is indicated

A CRC error that occurs on an address ID field will set bit 3 also. Table 6 shows how bits 1 and 3 are related

TABLE 6 — RELATIONSHIP OF CRC ERROR AND SECTOR ADDRESS UNDETECTED

| CRC Error (STRB 1) | Sector Address Undetected (STRB 3) | Condition |
|-----------------------|---|-------------------------------|
| 0 | 0 | No Error |
| 0 | 1 | Sector Address not Detected |
| 1 | 0 | CRC Error on a Data Field |
| 1 | 1 | CRC Error on Address ID Field |

Bit 4: Seek Error

An STZ (Seek Track Zero) command that never receives a track zero indication on the track zero input will result in a Seek Error (see description of STZ command)

Bit 5: File Inoperable

The state of the File Inoperable input appears in bit 5. If the File Inoperable input is a '1', a pulse of width 1/f (where f= Frequency of the clock input) is issued on the FIR output when STRB is read. FI is not latched but the input is gated to the bus when STRB is read.

Bit 6: Write Error

If the WPT input becomes a high level (logic '1') during the execution of a write command the write error bit is set.

Bit 7: Hard Error

If the Ready input becomes a '0' during the operation of a command (Busy is set), a hard error indication will result

GENERAL COUNT REGISTER (GCR)

Hex address 5, write only

| | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | | | |
|---|-------|-------|---|-------|-------|-------|-------|-------|--|--|--|
| Γ | Not | 7 Bit | 7 Bit Count for Track Number on SEK Command | | | | | | | | |
| | Used | and | and Sector Count for MSR or MSW Command | | | | | | | | |

The GCR contains the destination track address for the R/W head on an SEK Macro Command. The contents of the GCR are transferred to the CTAR at the end of the SEK Command. For multi-sector read or write operations (MSR, MSW), the GCR contains the number of sectors to be read minus one During the MSR or MSW execution the GCR is decremented after each sector is read or written.

CRC CONTROL REGISTER (CCR)

Hex address 6, write only

| В | lit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 |
|---|-------|-------|-------|-------|-------|-------|-------|---------------|
| | | | Not | Jsed | | | | CRC Enable |

The CCR information is used only in the free format commands, for all other commands this register is masked and has no function

Bit 0: CRC Enable

During an FFW command, CRC Enable is set by software and CRC generation takes effect on the next transfer of data from DOR to DOSR (see Figure 25) The CRC generation continues until Shift CRC (CCR bit 1) is set

For an FFR command, CRC Enable is set by software and CRC generation takes effect on the next data read from DIR The calculation continues for all data bytes read from DIR until CRC Enable is reset. The bytes read previous to resetting CRC Enable are considered the CRC information bytes and the CRC check is made against them.

Bit 1: Shift CRC

Bit 1 is valid only for the FFW command. After setting, it takes effect on the next transfer of data from DOR to DOSR (see Figure 26). Setting Shift CRC terminates the CRC calculation and causes the CRC calculated on all the data written into DOR up to the setting of bit 1, to be shifted out the WDT output. The CRC calculation will not include any data written to DOR after Shift CRC is set.

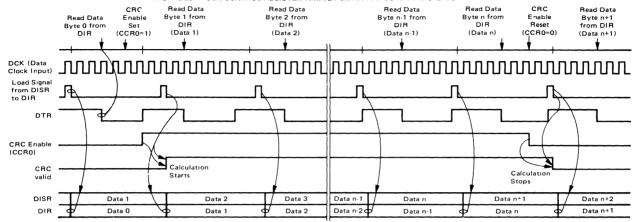
LTAR (LOGICAL TRACK ADDRESS)

Hex address 7, write only

| Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 |
|-------|-------|-------|----------|-----------|--------|-------|-------|
| Not | | | 7 Bit Lo | gical Tra | ck Add | ress | |
| Used | | | | | | | |

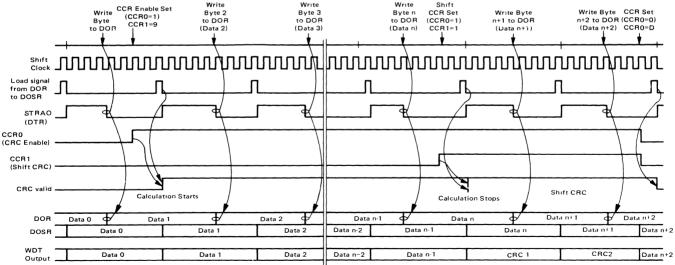
When a read or write macro command (SSW, SWD, SSR, RCR, MSW, MSR) is issued, the address of the track on which the operation is to be performed must be written into the LTAR. The address in the track address byte of an Address ID field of the disk is compared with the contents of the LTAR. The contents of LTAR are not affected by the execution of any of the commands.





CRC Calculation includes Data Byte 1 through Data Byte n





The CRC Calculation includes Data Byte 1 through Data Byte n-1

TABLE 7 - PROGRAMMING REFERENCE DATA

Table 7 is a summary of the information in the data sheet and can be used as a reference when programming the MC6843

| Registers | Hex Address | R/W Mode | | | 3,1000 0,100 | Data | Bits | or programm | ing the Mode | | |
|-----------|----------------|-------------|-------------------------------|------------------------------------|----------------------------------|---------------------------|-----------------------------------|---|--------------------------------------|--------------------------------|--|
| DOR | 0 | wo | Bit 7 | Bit 6 | Bit 5 8 Bits of | Bit 4 Data Used for | Bit 3 a Disk Write | Bit 2 Operation | Bit 1 | Bit 0 | |
| DIR | 0 | RO | Bit 7 | Bit 6 | Bit 5 8 Bits of | Bit 4 Data Used for | Bit 3 a Disk Read | Bit 2 Operation | Bit 1 | Bit 0 | |
| CTAR | 1 | R/W | Bit 7 Not Used | Bit 6 | Bit 5 | Bit 4 Bit Track Add | Bit 3 dress of Curre | Bit 2 nt Head Positi | Bit 1 | Bit 0 | |
| CMR | 2 | wo | Bit 7 Function Interrupt Mask | Bit 6 ISR3 Interrupt Mask | Bit 5 DMA Flag | Bit 4 | Bit 3 | Bit 2 * Macro C | Bit 2 Bit 1 Bit 0 | | |
| ISR | 2 | RO | Bit 7 | Bit 6 Not | Bit 5 Used | Bit 4 | Bit 3 * STRB | Bit 2 Bit 1 Bit 0 Status * Settling * Macro * Sense Time Command Request Complete Complete | | | |
| SUR · | 3 | wo | Bit 7 | Bit 6 Track to Trac | Bit 5 ck Seek Time | Bit 4 | Bit 3 | Bit 2 Head Sett | Bit 1 ling Time | Bit 0 | |
| STRA | 3 | RO | Bit 7 Busy | Bit 6 | Bit 5 Track * Not Equal | Bit 4 Write Protect | Bit 3 Track Zero | Bit 2 Drive Ready | Bit 1 Delete * Data Mark Detected | Bit 0 Data * Transfer Request | |
| SAR | 4 | wo | Bit 7 | Bit 6 Not Used | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | |
| STRB | 4 | RO | Bit 7 Hard Error | Bit 6 Write Error | Bit 5 File Inoperable | Bit 4 Seek Error | Bit 3 Sector * Address Undetected | Bit 2 Data * Mark Undetected | Bit 1 CRC Error | Bit 0 * Data Transfer | |
| GCR | 5 | wo | Bit 7 Not Used | Bit 6 7 E | Bit 5 | Bit 4 Frack Numbe | Bit 3 r on SEK or S | Bit 2 ector Count fo | Bit 1 or MSR or MS | Bit 0 | |
| CCR | 6 | wo | Bit 7 | Bit 6 | Bit 5 Not | Bit 4 Used | Bit 3 | Bit 2 | Bit 1 Shift CRC | Bit 0 CRC Enable | |
| LTAR | 7 | wo | Bit 7 Not Used | Bit 6 | Bit 5 | Bit 4 7 Bit 5 | Bit 3 Search Track A | Bit 2 | Bit 1 | Bit 0 | |

RO - Read Only

Read Only *Cleared by Reset

WO - Write Only R/W - Read/Write

MACRO COMMANDS

| Hex Code | Instruction | Hex Code | Instruction |
|----------|-------------|----------|-------------|
| 2 | STZ | Α | FFR |
| 3 | SEK | В | FFW |
| 4 | SSR | С | MSR |
| 5 | ssw | D | MSW |
| 6 | RCR | | |
| 7 | SWD | | |

TABLE 8

Table 8 is a list of all error flags showing what conditions will cause the error, the instructions for which they are valid, and what conditions reset them.

| Name | Flag | Set Condition | Reset Condtiion | Command |
|------------------------------|-------|--|--|--|
| Track Not Equal | STRA5 | The track address that is read from the disk does not coincide with the content of the LTAR | Upon issuance of SSW, SSR, SWD, RCR, MSR, MSW command | SSW, SSR, SWD, RCR, MSR, MSW |
| Data Transfer Error | STRB0 | During the data transfer between the drive and the MPU or memory, an overrun or underflow occurs | Reading of STRB | SSW, SSR, SWD, RCR, MSR, MSW, FFR, FFW |
| CRC Error | STRB1 | In checking the CRC of an ID field or a Data field, a CRC error occurs | Reading of STRB | SSW, SSR, SWD, RCR, MSR, MSW, (FFR) |
| Data Mark Undetected | STRB2 | If data address mark (FB or F8) is not detected within 32 bytes after the address ID field has been detected | Upon issuance of SSW, SSR, SWD, RCR, MSR, MSW Command | SSR, RCR, MSR |
| Sector Address Undetected | STRB3 | (1) The sector address that coincides with the contents of the SAR does not exist on the track (2) A CRC error occurs in checking the ID field | Reading of STRB | SSW, SSR, SWD, RCR, MSR, MSW |
| Seek Error | STRB4 | During a STZ command, the TKZ input remains low after 83 pulses have been issued on the STP output | Reading of STRB | STZ |
| FI | STRB5 | File Inoperable input is high | Reading STRB causes the FIR output to go High This should reset the FI input | SSW, SWD, MSW, FFW |
| Write Error | STRB6 | The WPT input is high, and a write operation is executed | Reading of STRB with either WGT or WPT reset. | SSW, SWD, MSW, FFW |
| Hard Error | STRB7 | During the execution of command (Busy is 1) the RDY input becomes low. | Reading of STRB | All commands |



MC6844 (1.0 MHz) MC68A44 (1.5 MHz) MC68B44 (2.0 MHz)

DIRECT MEMORY ACCESS CONTROLLER (DMAC)

The MC6844 Direct Memory Access Controller (DMAC) performs the function of transferring data directly between memory and peripheral device controllers. It directly transfers the data by controlling the address and data bus in place of an MPU in a bus organized system

The bus interface of the MC6844 includes select, read/write, interrupt, transfer request/grant, a data port, and an address port which allow data transfer over an 8-bit bidirectional data bus. The funtional configuration of the DMAC is programmed via the data bus. The internal structure provides for control and handling of four individual channels, each of which is separately configured. Programmable control registers provide control for data transfer location and data block length, individual channel control and transfer mode configuration, priority of channel servicing, data chaining, and interrupt control Status and control lines provide control to peripheral controllers

The mode of transfer for each channel can be programmed as one of two single-byte transfer modes or a burst transfer mode.

Typical MC6844 applications are a Floppy Disk Controller (FDC) and an Advanced Data Link Controller (ADLC) DMA interface

MC6844 features include

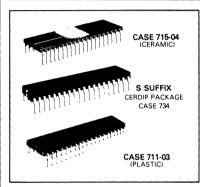
- Four DMA Channels, Each Having a 16-Bit Address Register and a 16-Bit Byte Count Register
- 2 M Byte/Sec Maximum Data Transfer Rate
- Selection of Fixed or Rotating Priority Service Control
- Separate Control Bits for Each Channel
- Data Chain Function
- Address Increment or Decrement Update
- Programmable Interrupts and DMA End to Peripheral Controllers

FIGURE 1 - M6800 MICROCOMPUTER FAMILY **BLOCK DIAGRAM** Microprocesso: Read Only Memory Random Memory Peripheral Controller MC6844 Direct emory Access Data Address Rus Bus

MOS

(N-CHANNEL, SILICON-GATE)

DIRECT MEMORY ACCESS CONTROLLER (DMAC)



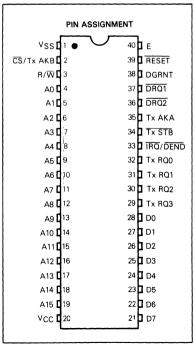
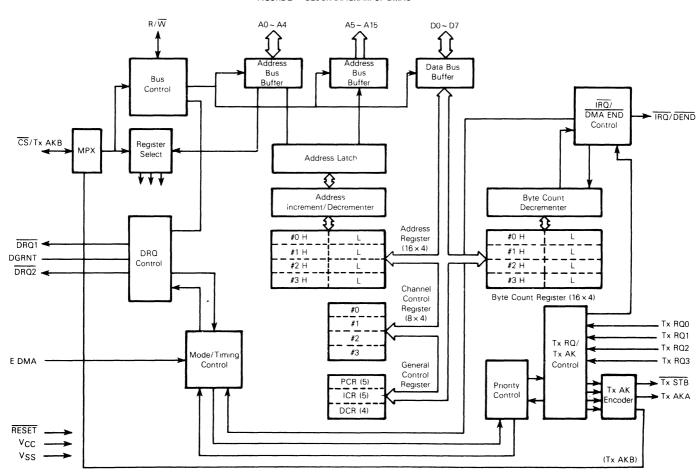


FIGURE 2 - BLOCK DIAGRAM OF DMAC



MAXIMUM RATINGS

| Rating | Symbol | Value | Unit |
|--|-------------------|--|------|
| Supply Voltage | vcc. | -0.3 to +7.0 | ٧ |
| Input Voltage | V _{in} * | -03 to +70 | ٧ |
| Operating Temperature Range MC6844, MC68A44, MC68B44 MC6844C, MC68A44C | ТА | T _L to T _H 0 to +70 -40 to +85 | °C |
| Storage Temperature Range | T _{stg} | -55 to +150 | °C |

This device contains circuitry to protect the inputs against damage due to high static voltages or electric fields, however, it is advised that normal precautions be taken to avoid application of any voltage higher than maximum rated voltages to this high-impedance circuit. Reliability of operation is enhanced if unused inputs are tied to an appropriate logic voltage level (e.g., either VSS or VCC).

THERMAL CHARACTERISTICS

| Characteristic | Symbol | Value | Unit |
|--|--------|-----------------|------|
| Thermal Resistance Plastic Ceramic Cerdip | θJA | 100 50 60 | °C/W |

POWER CONSIDERATIONS

The average chip-junction temperature, T_J, in °C can be obtained from

$$T_J = T_A + (P_D \bullet \theta_{JA})$$

Where.

(1)

T_A ≡ Ambient Temperature, °C

θJA≡Package Thermal Resistance, Junction-to-Ambient, °C/W

PD = PINT + PPORT

PINT≡ICC×VCC, Watts - Chip Internal Power

PPORT = Port Power Dissipation, Watts — User Determined

For most applications PPORT

PINT and can be neglected PPORT may become significant if the device is configured to drive Darlington bases or sink LED loads

An approximate relationship between PD and TJ (if PPORT is neglected) is

$$P_D = K - (T_J + 273$$
°C)

(2)

Solving equations 1 and 2 for K gives

$$K = P_D \bullet (T_A + 273 \circ C) + \theta_{JA} \bullet P_D^2$$

Where K is a constant pertaining to the particular part. K can be determined from equation 3 by measuring PD (at equilibrium) for a known T_A . Using this value of K the values of PD and T_J can be obtained by solving equations (1) and (2) iteratively for any value of T_A .

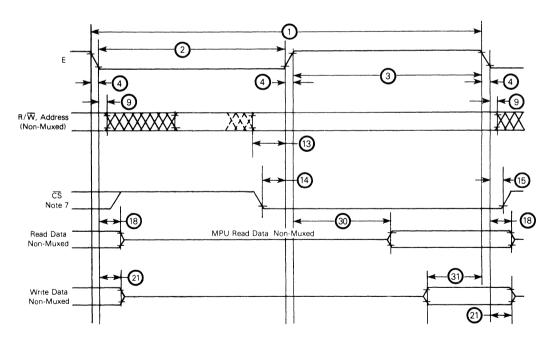
DC ELECTRICAL CHARACTERISTICS ($V_{CC} = 5.0 \text{ Vdc} \pm 5\%$, $V_{SS} = 0$, $T_A = T_L \text{ to } T_H \text{ unless otherwise noted}$)

| Characteristic | | Symbol | Min | Тур | Max | Unit |
|---|-------------------------------------|------------------|---|-------------|--|------|
| Input High Voltage | All Inputs | VIH | V _{SS} +20 | - | Vcc | ٧ |
| Input Low Voltage | CS/Tx AKB Other Inputs | VIL | V _{SS} -03 V _{SS} -03 | _ | V _{SS} +06 V _{SS} +08 | V |
| Input Leakage Current (V _{In} = 0 to 5 25 V) | Tx RQ0-3, E, RESET, DGRNT | l _{in} | _ | _ | 25 | μА |
| Three-State Leakage Current (V _{In} = 0 4 to 2 4 V) | A0-A15, R/W D0-D7 | ITSI | - 10 | - | 10 | μА |
| Output High Voltage ($I_{Load} = -205 \mu\text{A}$ ($I_{Load} = -145 \mu\text{A}$) ($I_{Load} = -100 \mu\text{A}$) | D0-D7 A0-A15, R/W All Others | Vон | V _{SS} +24 V _{SS} +24 V _{SS} +24 | - - - | - - - | ٧ |
| Output Low Voltage (I _{Load} = 1 6 mA) | All Others | VOL | - | - | V _{SS} +04 | V |
| Source Current (V _{IN} = 0 V, Figure 10) | CS/Tx AKB | ICSS | | 10 | 16 | mA |
| Internal Power Dissipation (Measured at $T_A = T_L$ to T_H |) | PINT | | 500 | 750 | mW |
| Capacitance ($V_{IN} = 0$, $T_A = 25$ °C, $f = 10$ MHz) | D0-D7, CS, A0-A4, R/W All Others | C _{in} | - - - | - - - | 20 12 5 10 | pF |
| | | C _{out} | - | | 12 | pF |

MPU MODE TIMING (See Notes 1 and 2)

| ldent. | Ch anadaniata | Combal | MC6844 | | MC68A44 | | MC68B44 | | Unit |
|--------|-----------------------------------|---------------------|--------|------|---------|------|---------|------|------|
| Number | Characteristic | Symbol | Min | Max | Min | Max | Min | Max | Onic |
| 1 | Cycle Time | tcyc | 10 | 10 | 0 67 | 10 | 05 | 10 | μS |
| 2 | Pulse Width, E Low | PWEL | 430 | 9500 | 280 | 9500 | 210 | 9500 | ns |
| 3 | Pulse Width, E High | PWEH | 450 | 9500 | 280 | 9500 | 220 | 9500 | ns |
| 4 | Clock Rise and Fall Time | t _r , tf | _ | 25 | _ | 25 | _ | 20 | ns |
| 9 | Address Hold Time | tAH | 10 | | 10 | _ | 10 | - | ns |
| 13 | Address Setup Time Before E | tAS | 80 | _ | 60 | _ | Т | BD | ns |
| 14 | Chip Select Setup Time Before E | tcs | 80 | - | 60 | _ | 40 | - | ns |
| 15 | Chip Select Hold Time | tCH | 10 | - | 10 | - | 10 | - | ns |
| 18 | Read Data Hold Time | tDHR | 20 | - | 20 | _ | 20 | _ | ns |
| 21 | Write Data Hold Time | tDHW | 10 | _ | 10 | _ | 10 | - | ns |
| 30 | Peripheral Output Data Delay Time | †DDR | _ | 290 | - | 180 | Т | BD | ns |
| 31 | Peripheral Input Data Setup Time | tDSW | 165 | _ | 80 | l – | 60 | _ | ns |

FIGURE 3 - MPU MODE TIMING



NOTES

- 1 Voltage levels shown are V_L \leq 0 4 V, V_H \geq 2 4 V, unless otherwise specified 2 Measurement points shown are 0 8 V and 2 0 V, unless otherwise specified

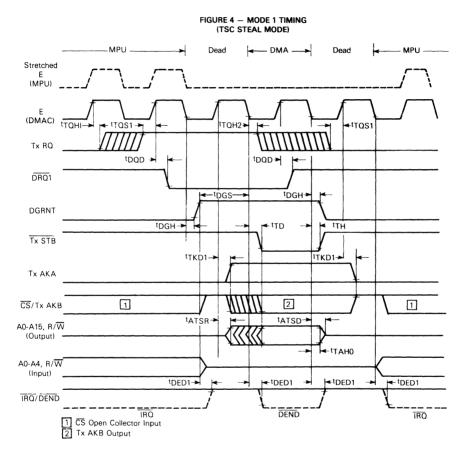


FIGURE 5 — MODE 2 TIMING (HALT STEAL MODE)

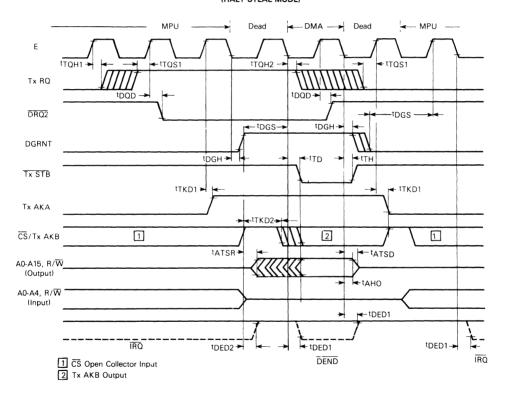
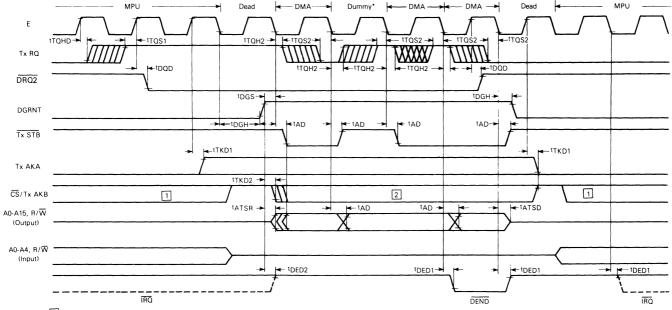


FIGURE 6 — MODE 3 TIMING (HALT BURST MODE)



¹ CS Open Collector Input

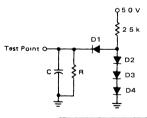
² Tx AKB Output

^{*}No transfer (dummy cycle) because Tx RQ was negated at start of E cycle

DMA TIMING (Load Condition Figure 7)

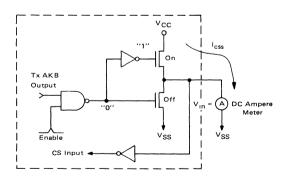
| Characteristic | Symbol | MC | 6844 | MC6 | BA44 | MC6 | 8B44 | Unit |
|---|-------------------|-----|----------|-----|------|-----|------|------|
| Characteristic | Symbol | Min | Max | Min | Max | Min | Max | Unit |
| Tx RQ Setup Time | | | | | | | | |
| E Rising Edge | tTQS1 | 120 | - | 120 | - | 120 | - | ns |
| E Falling Edge | tTQS2 | 210 | | 210 | _ | 170 | | |
| Tx RQ Hold Time | | | | i | | | | |
| E Rising Edge | tTQH1 | 20 | - | 10 | - | 10 | - | ns |
| E Falling Edge | tTQH2 | 20 | <u> </u> | 10 | | 10 | | L |
| DGRNT Setup Time | tDGS | 155 | | 125 | _ | 115 | | ns |
| DGRNT Hold Time | tDGH | 10 | _ | 10 | - | 10 | _ | ns |
| Address Output Delay Time A0-A15, R/W | tAD | _ | 270 | _ | 180 | _ | 150 | ns |
| Address Output Hold Time A0-A15, R/W | tAHO | 30 | | 20 | | 20 | | ns |
| Address Three-State Delay Time A0-A15, R/\overline{W} | tATSD | _ | 720 | - | 460 | | 370 | ns |
| Address Three-State Recovery Time | tATSR | _ | 430 | _ | 280 | | 210 | ns |
| Delay Time DRQ1, DRQ2 | tDQD | - | 375 | _ | 250 | _ | 200 | ns |
| Tx AK Delay Time | | | | | | | | |
| E Rising Edge | tTKD1 | - | 400 | _ | 310 | - | 250 | ns |
| DGRNT Rising Edge | [†] TKD2 | | 190 | _ | 160 | | 145 | |
| IRQ/DEND Delay Time | | , | | | | | | |
| E Falling Edge | tDED1 | - | 300 | - | 250 | - | 230 | ns |
| DGRNT Rising Edge | tDED2 | | 190 | _ | 160 | | 145 | |
| Tx STB Output Delay Time | tTD | | 270 | | 180 | | 150 | ns |
| Tx STB Output Hold Time | tTH | _ | 20 | _ | 20 | _ | 20 | ns |

FIGURE 7 - TEST LOADS



| Test Pin | C = pF | $R = k\Omega$ |
|-------------|--------|---------------|
| D0-D7 | 130 | 11 7 |
| A0-A15, R/W | 90 | 16 5 |
| CS/Tx AKB | 50 | 24 |
| Others | 30 | 24 |

FIGURE 8 — CS/Tx AKB SOURCE CURRENT TEST CIRCUIT



INTRODUCTION

The MC6844 DMAC has four DMA channels which can be independently configured by software using fifteen addressable registers. Eight of the addressable registers are 16-bit registers, and seven are 8-bit registers Associated with each channel are a 16-bit Address Register, a 16-bit Byte Control Register, and an 8-bit Channel Control Register. The DMAC also has three 8-bit registers which affect all of the channels: the Priority Control Register, the Interrupt Control Register, and the Data Chain Register. A block diagram of the DMAC is presented in Figure 2.

SOFTWARE INITIALIZATION

A channel is initialized for DMA by loading the channel address register with the desired starting DMA address and the channel byte control register with the number of bytes to be transferred In addition, the channel control register must be initialized for the direction of data transfer, for address register increment or decrement after each byte transfer, and for DMA transfer mode.

Each channel can be initialized for one of three transfer modes Mode 1, Mode 2, or Mode 3. Two read-only status bits in the channel control register indicate when the channel is busy transferring a block of data and when the DMA transfer of a block of data is complete

The priority control register, the interrupt control register, and the data chain registers must also be initialized

The priority control register enables/disables each channel and determines whether channel service requests are serviced in a fixed or a rotating prority. The interrupt control register controls assertion of IRQ interrupt by each channel at the end of a data block transfer and sets a flag when IRQ is asserted. The data channer register controls selection of two or four channel operation, selection of data chaining operation, and the channel to be updated in the data chaining mode.

When data chaining is enabled, the contents of the channel 3 address and byte count registers are stored into the corresponding registers of the channel selected for chaining after the channel data block transfer is completed This feature allows for repetitively reading or writing a block of memory

HARDWARE INITIALIZATION

At power-on reset (POR) and anytime $\overline{\text{RESET}}$ is asserted, all device registers except the address and byte count registers are cleared. Therefore, the state of the DMAC after reset is as follows

- all DMA channels are disabled,
- all interrupts are disabled,
- · all flags are cleared,
- address register decrement is selected for each channel,
- mode 2 is selected for each channel,
- peripheral controller wirte-to-memory is selected for each channel.
- two-channel operation is selected, and
- data chaining is disabled

DMAC BUS CONTROL

During DMA operation, the DMAC controls the system address and data buses and generates system R/\overline{W} The DMAC also generates Tx STB, which can be used to derive system VMA, Tx AKA and Tx AKB, which can be used to identify which DMA channel is in service, $\overline{DRQ1}$ and $\overline{DRQ2}$, which are used for handshaking with the system MPU, \overline{DEND} , which is asserted when the last byte of a data block is being transferred, and \overline{IRQ} , which when enabled will interrupt the system MPU when a data block transfer is completed Data itself does not pass through the DMAC, but is transferred between memory and peripheral under control of the DMAC

TRANSFER MODES

Each DMAC channel can be programmed to operate in one of three modes * Two of the modes, mode 1 and mode 2, are single-byte transfer modes in which the DMAC returns the bus to the MPU after each DMA transfer by negating the appropriate DMA Request (DRQ1 or DRQ2). These modes are intended to be used in applications requiring the MPU to regain control of the bus after each byte transfer. Timing information for modes 1 and 2 is presented in Figures 4 and 5.

Mode 3 is a block transfer mode in which the DMAC retains control of the bus until the last byte of the DMA data block has been transferred (byte control register 0), if DGRNT remains asserted during the entire block transfer. In mode 3, byte transfers are possible at the DMAC clock frequency by asserting Tx RQ each cycle. This mode offers the highest DMA transfer rate. Mode 3 timing is presented in Figure 6.

A flowchart of DMAC operation in each mode is presented in Figure 9

FUNCTIONAL PIN DESCRIPTIONS

VCC AND VSS

VCC and VSS provide power to the DMAC. The power supply should provide $\pm 5~V~\pm 5\%$ to VCC. VSS should be tred to ground. Total power dissipation will not exceed PD milliwatts.

RESET

This input is used to place the DMAC into a known state and provide for an orderly startup procedure. Assertion of RESET clears all internal registers except the address and the byte count registers (see Hardware Initialization)

E (ENABLE)

This TTL-compatible input is used to clock the DMAC with the MPU E clock. In systems that perform single-byte transfers by stretching the MPU clock rather than by halting the MPU, the system must be designed to provide a non-stretched E clock to this pin. Clock modules such as the MC6875 are available which provide a separate stretchable E clock to externally-driven MPUs and a non-stretched clock to the DMAC.

^{*}Modes 1, 2, and 3 are also called TSC Steal, HALT Steal, and HALT Burst modes

RESET Initial State Wait for Programming No BCR≠"0" Tx EN = "1"? Yes Wait for Tx RQ Input Tx RQ="1"? Checked E Yes DRQ1/DRQ2="0" Output Wait for Tx RQ Input No Tx RQ="1" DGRNT = "1"? Checked E Yes DMA Transfer (A0~A15, R/W, Tx STB, Tx AKA/B Output Address +1 Number of Transfer Words -1 = 0BCR = "0" **≠**0 Burst DRQ1/DRQ2="1" Burst/Cycle Mode Steal? Output Cycle Steal Mode DRQ1/DRQ2="1" TRQ/DEND = "0" Output Output

FIGURE 9 - FLOWCHART OF DMAC OPERATION

READ/WRITE (R/W)

This TTL-compatible bidirectional line is a high-impedance input when the DMAC is off the system bus (MPU mode), and an output when the DMAC is controlling the bus (DMA mode). In the MPU mode, this input is used to control the direction of data transfer through the DMAC data bus interface to allow MPU reads and writes to internal registers. In the DMA mode, Read/Write is an output to the system bus, with its state controlled by bit 0 of the appropriate channel control register.

ADDRESS A0-A15

Address lines A0-A4 are bidirectional. In the MPU mode, these lines are inputs used by the MPU to address DMAC registers. In the DMA mode, these lines and lines A5-A15 are outputs which assert the contents of the address register of the channel being serviced. Address lines A0-A15 are TTL compatible.

DATA D0-D7

These bidirectional TTL-compatible lines are used for data transfer between the MPU and the DMAC. These lines remain in the high-impedance state except when the MPU reads DMAC registers.

INTERRUPT REQUEST/DMA END (IRQ/DEND)

Interrupt Request/DMA End is a TTL-compatible, time-multiplexed, active low output used to interrupt the MPU and signal a peripheral controller when a DMAC data block transfer has ended DEND is asserted during the transfer of the last data byte of a block transfer for one E clock cycle (see Figures 4, 5, and 6). IRQ is asserted after the last byte transfer of a block transfer if enabled by setting the proper DEND IRQ enable bit in the interrupt control register (see Table 2). Once asserted, IRQ is negated by reading the channel control register of the channel asserting the interrupt.

TRANSFER REQUEST (Tx RQ0-3)

Associated with each channel is a high-impedance input pin used by a peripheral controller to request DMA service by the channel. The Tx RQ pins are sampled by the DMAC in an order of priority determined by the software-programmable state of the priority control register. The Tx RQ pins for channels programmed for mode 1 or mode 2 operation (single-byte transfer modes) are sampled on the rising edge of E If Tx RQ for one of these channels is asserted when sampled, the DMAC will perform one DMA byte transfer for the channel before sampling the Tx RQ pin of the channel next in the priority. The Tx RQ pins for channels programmed for mode 3 operation (block transfer mode) are sampled on the rising edge of E for the first DMA byte transfer only If a Tx RQ for one of these channels is asserted when sampled, the first byte of the channel data block is transferred, then the Tx RQ pin is sampled on falling edges of E for subsaquent byte transfers (see Figure 6) Once a channel programmed for mode 3 operation begins DMA, that channel has priority of servicing until the channel completes its entire block transfer

DMA REQUEST 1-2 (DRQ1, DRQ2)

These active low TTL-compatible outputs are used by the DMAC to handshake with the MPU in requesting the system bus for DMA operation $\overline{DRQ1}$ is asserted to indicate that a channel configured for mode 1 operation requires servicing, and $\overline{DRQ2}$ is asserted to indicate that a channel configured for mode 2 or mode 3 operation requires servicing. Once asserted, each output remains asserted until the DMAC completes one DMA byte transfer in mode 1 and mode 2 DMA, or an entire byte block transfer in mode 3 DMA

DMA GRANT (DGRNT)

This high-impedance input is used to enable MC6844 DMA operation and should be asserted only after the MPU has relinquished the system bus to the DMAC Typically, DGRNT will be asserted by the MPU in response to a DMA request, indicating that the system bus is available for DMA

TRANSFER STROBE (Tx STB)

 $\overline{\text{Tx STB}}$ is asserted during each DMA transfer cycle and can be used as a transfer acknowledge for peripheral controllers and as a system VMA $\overline{\text{Tx STB}}$ is a TTL-compatible output

TRANSFER ACKNOWLEDGE A (Tx AKA)

Transfer Acknowledge A is asserted during DMA operation and can be used with Tx AKB to identify the DMA channel being serviced, as shown in Table 1

CHIP SELECT/TRANSFER ACKNOWLEDGE B

This bidirectional pin serves two functions. During MPU operation it is a chip-select input which when asserted allows MPU access to the DMAC registers. During DMA transfers this pin is for Tx AKB output, used with Tx AKA to identify the DMA channel being serviced (see Table 1).

TABLE 1 - ENCODING ORDER

| CS/Tx AKB | Tx AKA | Channel # |
|-----------|--------|-----------|
| 0 | 0 | 0 |
| 0 | 1 | 1 |
| 1 | 0 | 2 |
| 1 | 1 | 3 |

DMAC REGISTERS

All DMAC registers are read/write registers, although some of the register status bits are read-only Table 2 presents a summary of the DMAC control registers, and Table 3 lists address and byte count register addresses.

ADDRESS REGISTERS

Associated with each DMA channel is an address register which stores the 16-bit address to be asserted on the system

TABLE 2 - DMAC CONTROL REGISTERS

| Register | Address | | | | Register | Content | | | |
|----------------------|---------|---------------------------|--------------------|----------|----------|-------------------------------------|-----------------------------------|-----------------------------------|---------------------------------|
| Negistei | (Hex) | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 |
| Channel Control | 1x* | DMA End Flag (DEND) | Busy/Ready Flag | Not Used | Not Used | Address Up/Down | MCA | ′ мсв | Read/Write (R/W) |
| Priority Control | 14 | Rotate Control | Not Used | Not Used | Not Used | Request Enable #3 (RE3) | Request Enable #2 (RE2) | Request Enable #1 (RE1) | Request Enable #0 (RE0) |
| Interrupt Control | 15 | DEND IRQ Flag | Not Used | Not Used | Not Used | DEND IRQ Enable #3 (DIE3) | DEND IRQ Enable #2 (DIE2) | DEND IRQ Enable #1 (DIE1) | DEND IRQ Enable #0 (DIE0) |
| Data Chain | 16 | Not Used | Not Used | Not Used | Not Used | Two/Four Channel Select (2/4) | Data Chain Channel Select B | Data Chain Channel Select A | Data Chain Enable |

^{*}The x represents the binary equivalent of the channel desired

TABLE 3 - ADDRESS AND BYTE COUNT REGISTERS

| Register | Channel | Address (Hex) |
|-----------------|---------|------------------|
| Address High | 0 | 0 |
| Address Low | 0 | 1 |
| Byte Count High | 0 | 2 |
| Byte Count Low | 0 | 3 |
| Address High | 1 | 4 |
| Address Low | 1 | 5 |
| Byte Count High | 1 | 6 |
| Byte Count Low | 1 | 7 |
| Address High | 2 | 8 |
| Address Low | 2 | 9 |
| Byte Count High | 2 | A |
| Byte Count Low | 2 | В |
| Address High | 3 | С |
| Address Low | 3 | D |
| Byte Count High | 3 | E |
| Byte Count Low | 3 | F |

address bus during the next DMA cycle of the channel. After each DMA byte transfer, the address register will increment or decrement according to the state of bit 3 of the appropriate channel control register. The starting address of a DMA data block should be stored in the address register of a channel to be used before beginning DMA operation with the channel.

BYTE COUNT REGISTERS

Each channel has a 16-bit byte count register which stores the number of DMA cycles remaining in a channel DMA block. This register should be loaded with the number of

bytes to be transferred by a channel before the channel begins DMA. The byte count register is decremented at the beginning of a DMA cycle.

CHANNEL CONTROL REGISTERS

A channel control register associated with each channel is used to control the channel mode of operation, the state of the R/\overline{W} line during DMA, and whether the channel address register will increment or decrement after each DMA cycle The channel control registers contain two read-only status flags which report the status of the channel. The channel control register bits are defined as follows

Bit 0 R/W

Read/Write The direction of DMA transfer is determined by the state of this bit. When this bit is a "11", R/W will be asserted high by the DMAC during DMA, and memory will be read by the peripheral controller. When this bit is a "0", R/W will be asserted low by the DMAC during DMA and data transfer will be from the peripheral controller to memory.

Bit 1 MCB

Mode Control B This bit is used to select the channel DMA mode When this bit is a "1", mode 3 operation is selected When this bit is clear, either mode 1 or mode 2 operation is selected according to the state of channel control register bit 2 Table 4 shows the DMA mode options.

TABLE 4 - DMA MODE SELECT

| MCA | МСВ | DMA Transfer Mode |
|-----|-----|-------------------|
| 0 | 0 | Mode 2 |
| 0 | 1 | Mode 3 |
| 1 | 0 | Mode 1 |
| 1 | 1 | Undefined |

Bit 2 MCA

Mode Control A. This bit is used with MCR to select the channel DMA mode. When MCB is set, this bit must be clear and mode 3 operation is selected. Setting both MCA and MCB to a "1" places the DMAC into an undefined mode of operation With MCB clear, setting MCA to a "1" places the channel into mode 1 and clearing MCA places the channel into mode 2 (see Table 2).

Bit 3

Address Up/Down Bit 3 controls address register increment/decrement during DMA If this bit is set to a "1", the address register increments with each DMA cycle, if it is clear, the address register decrements with each DMA cycle

Bits 4-5

Not used

Bit 6

Busy/Ready Flag The Busy/Ready flag is read-only status bit that indicates a DMA block transfer is in progress in the channel. After initializing the channel for a block transfer (address register, byte count register, etc.), this flag sets when Tx RQ is recognized and clears during the last block byte transfer

Bit 7 DEND

DMA End Flag (DEND) The DEND flag is used to indicate when a DMA transfer is complete. This flag is set during the transfer of the last byte of a DMA block and is cleared by reading the channel control register. This flag will generate an IRQ interrupt if enabled in the interrupt control register

PRIORITY CONTROL REGISTER

The Priority Control Register is used to individually enable each DMA channel and to select the channel service priority scheme, with bits defined as follows

Bits 0-3 RE0-3 Request Enable 0-3 Each DMA channel is individually enabled by setting the appropriate RE bit (RE0 for channel 0 etc.) in the priority control register A clear channel RE bit inhibits recognition of Tx RQ for the channel

Bits 4-6

Not used

Bit 7

Rotate Control One of two channel service priority schemes can be selected by bit 7 When this bit is "0", the fixed priority of servicing is selected in which channel 0 has highest priority, channel 1 has the next highest priority, channel 2 the next highest priority, and channel 3 the last priority. When this bit is set to a "1", the rotating priority of servicing is selected. Rotating priority is initially the same as fixed priority, in that the lower numbered channels initially have the higher priroities However, once a channel is serviced in the rotating priority mode, that channel is given last priority of servicing. In this scheme the channel last serviced gets the last priority

INTERRUPT CONTROL REGISTER

The interrupt control register allows the user to selectively enable each channel IRQ interrupt. When enabled, an IRQ is generated when a DMA block transfer is complete. The interrupt control register also has a flag to indicate that the DMAC IRQ is asserted Interrupt control register bits are defined as follows:

Bits 0-3 DIE0-3 DEND IRQ Enable These bits enable individual channel IRQ interrupts when set to "1", and mask these interrupts when cleared The register bit number is the same as the channel number controlled by the bit. An IRQ is asserted only when a DMA block transfer is completed

Bits 4-6

Bit 7

DEND IRQ Flag This read-only bit is set to a "1" when the DMAC IRQ is asserted, indicating the end of a channel block transfer (DEND assertion) with interrupt enabled This flag is cleared and IRQ is negated by a read of the channel control register of the channel causing the IRQ interrupt.

DATA CHAIN REGISTER

Repetitive reading or writing of a block of memory can best be performed using the data chain function. This function transfers the contents of the channel 3 address and byte count registers into the respective registers of the channel selected for data chaining. These contents are transferred during the E cycle following the transfer of the last byte of a block by the selected channel The data chain register is defined as follows:

Bit 0 DCE

Data Chain Enable Data chaining is enabled when this bit is set to a "1" When this bit is clear, data chaining is disabled

Bit 1-2 DCA/B Data Chain Select A, B The state of these two bits determine which channel will be updated when data chaining is enabled, as listed in Table 5

Bit 3

Two/Four Channel Select The DMAC will operate with either two channels or four channels, depending on the state of this bit When this bit is set to a "1", the fourchannel mode is selected, and all four channels are selectable. When this bit is clear, the two-channel mode is selected and only channels 0 and 1 are selectable

Bits 4-7 Not used

TABLE 5 - CHANNEL SELECT

| DCB Bit 2 | DCA Bit 1 | Channel # |
|-----------|-----------|-----------|
| 0 | 0 | 0 |
| 0 | 1 | 1 |
| 1 | 0 | 2 |
| 1 | 1 | Undefined |

APPLICATIONS

The MC6844 DMAC can be interfaced to a wide variety of MPUs, including the Motorola MC68000. This section offers examples of MC6844 interface circuits that can be used as starting points in designing the DMAC into a particular system.

IRQ. DEND. Tx AK GENERATION

Derivation of $\overline{\text{IRQ}}$ (Interrupt Request), DEND (DMA End), and Tx AK (Transfer Acknowledge) for one, two, and four-channel DMA is shown in Figure 10 IRQ, if enabled, is asserted by the DMA to interrupt the MPU whenever a DMA block transfer is completed. Tx AK is asserted during each DMA cycle and is used to handshake with a peripheral controller each time a DMA byte transfer occurs DEND is used to handshake with a peripheral controller each time a DMA block transfer is complete

 $\underline{\text{Each}}$ circuit uses DMA GRANT to demultiplex the IRQ/DEND DMAC output to ensure that the system $\overline{\text{IRQ}}$ is asserted at the proper time, only during MCU operation Whenever DMA GRANT is high, $\overline{\text{IRQ}}$ is negated

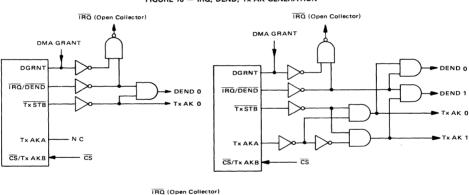
The circuits also generate DEND and Tx AK for the proper channel, gated by Tx STB

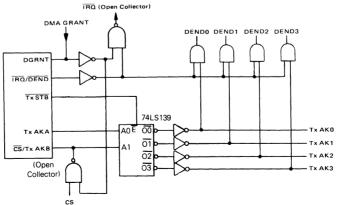
The one-channel DMA mode requires no channel decoding, so for this mode Tx AK is derived from $\overline{\text{Tx}}$ STB directly, and $\overline{\text{Tx}}$ STB is used to demultiplex the $\overline{\text{IRQ}}/\text{DEND}$ output for DEND generation

The two-channel mode circuit is similar to the one-channel circuit, but uses Tx AKA to identify the active channel and generate the appropriate channel signal (see Table 1)

The four-channel circuit is functionally similar to the two-channel circuit but uses a 74LS139 to decode Tx AKA and Tx AKB for channel identification. The DMAC CS/Tx AKB pin is bidirectional during four-channel operation, so an open collector gate must be used to drive CS in order to avoid drive contention.

FIGURE 10 - IRQ, DEND, Tx AK GENERATION





MC69000 BUS ARBITRATION INTERFACE

Figure 11 shows an MC6844/MC68000 interface for DMAC mode 2 or mode 3 operation. The MC68000 Advanced Information Data Sheet should be consulted for complete understanding of the circuit

The MC6844 must be initialized for transfer mode, byte count, DMA starting address, etc.

Initially DGRNT is low, BGACK output is high, and Tx STB is high. The MC6844 responds to a Tx RQ by asserting DRQH. Assertion of Tx RQ also asserts MC68000 BR For DMA transfer, two conditions must be met 1) DMAC DRQH must be asserted and 2) all bus masters must relinquish the system bus. Once DRQH is asserted it remains asserted low until DMA byte transfer in the halt-steal mode or until the last byte of a DMA memory block is being transferred in the halt-burst mode. A relinquishing of the bus by all bus masters is indicated by negated BGACK, AS, and DTACK after the MC68000 asserts BG in response to a bus request.

When both conditions are met, the NAND flip-flop is set by assertion of LS138 $\overline{\text{O3}}$, asserting DGRNT and $\overline{\text{BGACK}}$ The DMAC then performs a byte transfer in the halt-steal mode or a block of byte transfers in the halt-burst mode

The NAND flip-flop is cleared on the rising edge of \overline{Tx} \overline{STB} after asserting during each DMA cycle in the halt-steal mode, and during the last DMA cycle of a DMA block in the halt-burst mode (see MC6844 timing diagrams)

Note that \overline{BR} to the MC68000 is negated when \overline{BGACK} is asserted, satisfying an MC68000 requirement

MC6800 BUS ARBITRATION INTERFACE

A typical system design, using the MC6800/MC6844, is shown in Figure 12. A clock generator/driver is used which will stretch the MPU clock during DMA operation while generating a non-stretched clock for system memory. Priority logic is used to give highest priority to refresh request, since memory refresh and DMA transfers must not occur during the same E cycles.

During mode 2 or 3 DMA operation, the clock generator has no control over DMA Grant. To prevent DMA operation in mode 1 during a memory refresh cycle, system E must be gated with refresh grant. DGRNT must be the ORed output of bus available (BA) and DMA grant from the clock generator in order to support all 3 DMA modes of operation.

During the DMA cycle, a system VMA signal must be generated by the DMAC. This is done by ORing Tx STB and the MPLI VMA line.

MC6844/MC6809 BUS ARBITRATION INTERFACE

An MC6844/MC6809 interface is presented in Figure 13 This circuit ensures that MC6809 DMA/BREQ is asserted only during Q high, an MC6809 requirement. The circuit will also generate a system VMA (valid memory address), often referred to as DMA VMA.

The MC6809 does not generate a $\overline{\text{VMA}}$ output since the only invalid address asserted by the MPU is \$FFFF with R/W asserted high. Therefore, an MC6809 system does not normally need a VMA circuit. When using the MC6844 for DMA in an MC6809 system, however, a $\overline{\text{VMA}}$ circuit is required since the address lines are floating during dead cycles between the MPU and DMA modes. Devices on the bus must be deselected during this time

Initially, in the MPU mode, $\overline{DRQ1/2}$ is negated (high level), and the Q output of U3 is high. The output of the exclusive OR gate U4 is therefore a low, inhibiting clocking of U3 by forcing the output of U5 to remain a low. When $\overline{DRQ1/2}$ is asserted low, the output of U4 changes to a high If the MC6809 Q output is high at this time, the output of U5 changes to a high, clocking U3. If the MC6809 Q output is low at this time, the output of U5 will be driven high on the next rising edge of Q, clocking U3. When U3 is clocked, the Q output of U3 changes to a low asserting MC6809 DMA/BREQ. The output of U4 at this time is a low, since both of the U4 inputs are low.

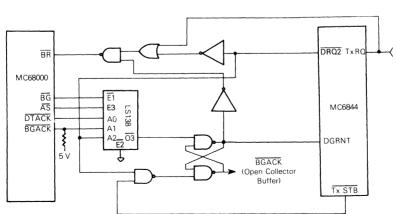


FIGURE 11 - MC68000/MC6844 INTERFACE

FIGURE 12 - MC6800/MC6844 INTERFACE

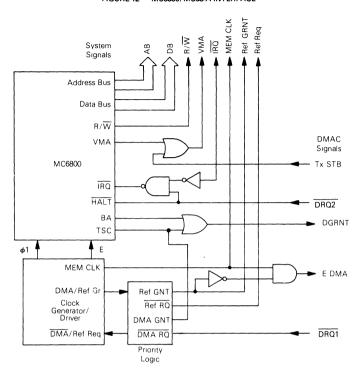
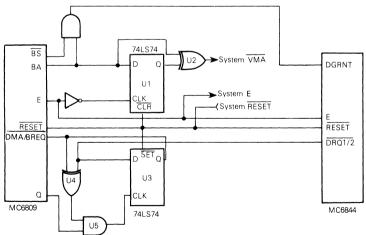


FIGURE 13 - MC6844/MC6809 INTERFACE



After the DMA transfer, DRQ1/2 is negated by the MC6844, forcing the output of U4 to a high. Once again, U3 will be clocked only when the MC6809 Q output is high

VMA is generated by U1 and U2 Initially, in the MPU mode, U1 is clear, with a low Q output. The BA (bus available) output of the MC6809 is also a low. Therefore, the output of U2 ($\overline{\text{VMA}}$) is low ($\overline{\text{VMA}}$ asserted). When the MC6809 asserts BA for DMA, the output of U2 becomes

high, indicating that the address on the system address bus is invalid during this dead cycle between MPU and DMA modes. On the next falling edge of E, U1 is clocked high forcing the output of U2 low during this DMA cycle. When BA is negated after DMA, the output of U2 is forced high until the next falling edge of E, indicating invalid address during this dead cycle.



MC6845 (1.0 MHz) MC68A45 (1.5 MHz) MC68B45 (2.0 MHz) MC6845 ☆ 1 (1.0 MHz) MC68A45 ☆ 1 (1.5 MHz) MC68B45 ☆ 1

(2.0 MHz)

CRT CONTROLLER (CRTC)

The MC6845 CRT Controller performs the interface between an MPU and a raster-scan CRT display. It is intended for use in MPU-based controllers for CRT terminals in stand-alone or cluster configurations.

The CRTC is optimized for the hardware/software balance required for maximum flexibility. All keyboard functions, reads, writes, cursor movements, and editing are under processor control. The CRTC provides video timing and refresh memory addressing.

- Useful in Monochrome or Color CRT Applications
- Applications Include "Glass-Teletype," Smart, Programmable, Intelligent CRT Terminals, Video Games, Information Displays
- Alphanumeric, Semi-Graphic, and Full-Graphic Capability
- Fully Programmable Via Processor Data Bus Timing May Be Generated for Almost Any Alphanumeric Screen Format, e.g., 80 x 24, 72 x 64, 132 x 20
- Single +5 V Supply
- M6800 Compatible Bus Interface
- TTL-Compatible Inputs and Outputs
- Start Address Register Provides Hardware Scroll (by Page, Line, or Character)
- Programmable Cursor Register Allows Control of Cursor Format and Blink Rate
- Light Pen Register
- Refresh (Screen) Memory May be Multiplexed Between the CRTC and the MPU Thus Removing the Requirements for Line Buffers or External DMA Devices
- Programmable Interlace or Non-Interlace Scan Modes
- 14-Bit Refresh Address Allows Up to 16K of Refresh Memory for Use in Character or Semi-Graphic Displays
- 5-Bit Row Address Allows Up to 32 Scan-Line Character Blocks
- By Utilizing Both the Refresh Addresses and the Row Addresses, a 512K Address Space is Available for Use in Graphics Systems
- Refresh Addresses are Provided During Retrace, Allowing the CRTC to Provide Row Addresses to Refresh Dynamic RAMs
- Programmable Skew for Cursor and Display Enable (DE)
- Pin Compatible with the MC6835

MAXIMUM RATINGS

| WAXIIVIOWI NATIINGS | | | |
|--|-------------------|---|------|
| Rating | Symbol | Value | Unit |
| Supply Voltage | V _{CC} * | -0.3 to $+7.0$ | ٧ |
| Input Voltage | V _{in} • | -0.3 to +7.0 | ٧ |
| Operating Temperature Range MC6845, MC68A45, MC68B45 MC6845C, MC68A45C, MC68B45C | TA | T _L to T _H 0 to 70 -40 to +85 | °C |
| Storage Temperature Range | T _{sta} | -55 to +150 | °C |

THERMAL CHARACTERISTICS

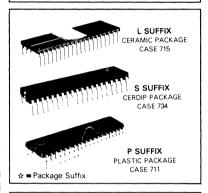
| Characteristic | Symbol | Value | Rating |
|--------------------|---------------|-------|--------|
| Thermal Resistance | | | |
| Plastic Package | 1 1 | 100 | 0000 |
| Cerdip Package | θ_{JA} | 60 | °C/W |
| Ceramic Package | _ | 50 | |

*This device contains circuitry to protect the inputs against damage due to high static voltages or electric fields, however, it is advised that normal precautions be taken to avoid application of any voltage higher than maximum rated voltages to this high-impedance circuit. For proper operation it is recommended that V_{III} and V_{OUT} be constrained to the range V_{SS} ≤ (V_{III} or V_{OUT}) ≤ V_{CC}

MOS

(N-CHANNEL, SILICON-GATE)

CRT CONTROLLER (CRTC)



| , FIGURE 1 — P | IN ASSIGNMENTS |
|-----------------------------|-----------------|
| GND 1 | 40 1 VS |
| RESET [2 | 39 1 HS |
| LPSTB D 3 | 38 3 RA0 |
| MA0 [4 | 37 1 RA1 |
| MA1 [5 | 36 1 RA2 |
| MA2 [6 | 35 1 RA3 |
| MA3 7 | 34 1 RA4 |
| MA4 [8 | 33 1 D0 |
| МА5Г 9 | 32 D D1 |
| MA6 [10 | 31 🗖 D2 |
| MA7 [11 | 30 J D3 |
| MA8 [12 | 29 1 D4 |
| MA9 [13 | 28 1 D5 |
| MA10 □ 14 | 27 1 D6 |
| MA11 [15 | 26 1 D7 |
| MA12 0 16 | 25 1 CS |
| MA13 [17 | 24 1 RS |
| DE [18 | 23 1 E |
| CURSOR 19 | 22 □ R/W |
| V _{CC} I 20 | 21 1 CLK |
| | |

FIGURE 2 - TYPICAL CRT CONTROLLER APPLICATION → AB Processor → DB Primary Bus **2**8 Secondary Bus High Speed Refresh 3-State CRTC Timing RAM Buffer Refresh Cursor, Display Memory Enable Addresses Latch Light Pen Circuit Row Addresses ROM Shift Video Character Register Output Generator

RECOMMENDED OPERATING CONDITIONS

HS VS

| Characteristics | Symbol | Min | Тур | Max | Unit |
|--------------------|--------|------|-----|------|------|
| Supply Voltage | Vcc | 4 75 | 50 | 5 25 | V |
| Input Low Voltage | VIL | -03 | - | 0.8 | V |
| Input High Voltage | VIH | 20 | - | Vcc | ٧ |

POWER CONSIDERATIONS

The average chip-junction temperature, TJ, in °C can be obtained from

$$T_{J} = T_{A} + (P_{D} \bullet \theta_{J} A) \tag{1}$$

Where

TA = Ambient Temperature, °C

θ J A ≡ Package Thermal Resistance, Junction-to-Ambient, °C/W

PD≡PINT+PPORT

PINT≡ICC×VCC, Watts - Chip Internal Power

PPORT = Port Power Dissipation, Watts - User Determined

For most applications PPORT ◆PINT and can be neglected PPORT may become significant if the device is configured to drive Darlington bases or sink LED loads

(2)

An approximate relationship between PD and TJ (if PPORT is neglected) is

 $P_D = K + (T_J + 273 °C)$

Solving equations 1 and 2 for K gives

 $K = P_{D} \bullet (T_{A} + 273 \circ C) + \theta_{JA} \bullet P_{D}^{2}$ (3)

Where K is a constant pertaining to the particular part. K can be determined from equation 3 by measuring PD (at equilibrium) for a known T_A . Using this value of K the values of PD and T_J can be obtained by solving equations (1) and (2) iteratively for any value of T_A .

DC ELECTRICAL CHARACTERISTICS ($V_{CC} = 5.0 \text{ Vdc} \pm 10\%$, $V_{SS} = 0$, $T_A = 0$ to 70°C unless otherwise noted, see Figures 3-5)

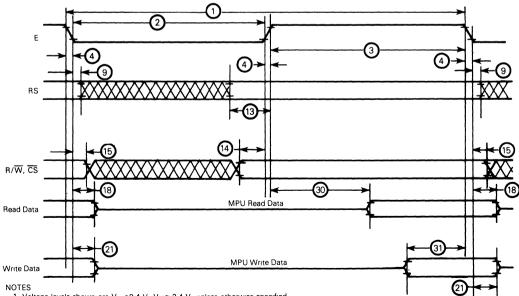
| Characteristic | Symbol | Min | Тур | Max | Unit | |
|---|---------------|-----------------|------|-----|------|----|
| Input High Voltage | | VIH | 20 | - | Vcc | ٧ |
| Input Low Voltage | | VIL | -03 | _ | 0.8 | V |
| Input Leakage Current | | lin | - | 01 | 25 | μА |
| Three-State (V _{CC} =5 25 V) (V _{In} =0 4 to 2 4 V) | | ITSI | - 10 | _ | 10 | μА |
| Output High Voltage | | | | | | |
| $(I_{Load} = -205 \mu\text{A})$ | D0-D7 | ∨он | 24 | 30 | _ | V |
| $(I_{Load} = -100 \mu\text{A})$ | Other Outputs | | 24 | 30 | _ | ĺ |
| Output Low Voltage (I _{Load} = 1 6 mA) | | VOL | _ | 03 | 0 4 | V |
| Internal Power Dissipation (Measured at TA=0°C) | | PINT | - | 600 | 750 | mW |
| Input Capacitance | D0-D7 | _ | - | _ | 12 5 | |
| | All Others | C _{in} | - | - | 10 | pF |
| Output Capacitance | All Outputs | Cout | _ | _ | 10 | pF |

BUS TIMING CHARACTERISTICS (See Notes 1 and 2) (Reference Figures 3 and 4)

| Ident. | Characteristic | Symbol | MC6845 vmbol MC6845☆ | | | 8A45 A45 ☆ 1 | MC68 | Unit | |
|--------|-----------------------------------|---------------------------------|-------------------------|------|------|-----------------|------|------|----|
| Number | | | Min | Max | Min | Max | Min | Max | 1 |
| 1 | Cycle Time | tcyc | 10 | 10 | 0 67 | 10 | 0.5 | 10 | μS |
| 2 | Pulse Width, E Low | PWEL | 430 | 9500 | 280 | 9500 | 210 | 9500 | ns |
| 3 | Pulse Width, E High | PWEH | 450 | 9500 | 280 | 9500 | 220 | 9500 | ns |
| 4 | Clock Rise and Fall Time | t _r , t _f | - | 25 | _ | 25 | - | 20 | ns |
| 9 | Address Hold Time (RS) | tAH | 10 | _ | 10 | - | 10 | - | ns |
| 13 | RS Setup Time Before E | tAS | 80 | - | 60 | - | 40 | _ | ns |
| 14 | R/W and CS Setup Time Before E | tCS | 80 | _ | 60 | _ | 40 | _ | ns |
| 15 | R/W and CS Hold Time | tCH | 10 | · – | 10 | - | 10 | - | ns |
| 18 | Read Data Hold Time | tDHR | 20 | 50* | 20 | 50* | 20 | 50° | ns |
| 21 | Write Data Hold Time | tDHW | 10 | - | 10 | _ | 10 | - | ns |
| 30 | Peripheral Output Data Delay Time | tDDR | T- | 290 | _ | 180 | 0 | 150 | ns |
| 31 | Peripheral Input Data Setup Time | tDSW | 165 | _ | 80 | - | 60 | _ | ns |

^{*}The data bus output buffers are no longer sourcing or sinking current by tDHR max (high impedance)

FIGURE 3 - MC6845 BUS TIMING



- 1 Voltage levels shown are $V_L \le 0.4 \text{ V}$, $V_H \ge 2.4 \text{ V}$, unless otherwise specified
- 2 Measurement points shown are 0 8 V and 2 0 V, unless otherwise specified

FIGURE 4 - BUS TIMING TEST LOAD

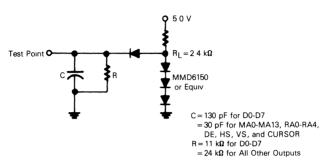
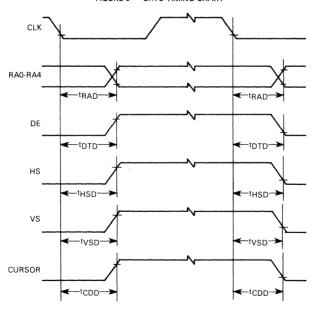


FIGURE 5 - CRTC TIMING CHART



NOTE Timing measurements are referenced to and from a low voltage of 0.8 volts and a high voltage of 2.0 volts unless otherwise noted

CLK

PWCL

PWCH

PWCH

PWCH

PWCH

PWCH

PWCH

PWCH

Item to the company and this period, the CRTC sets the Refresh Memory Address 'M + 2' into the LIGHT PEN REGISTER

FIGURE 6 - CRTC-CLK, MA0-MA13, AND LPSTB TIMING

tLPD1, tLPD2 Period of uncertainty for the Refresh Memory Address

NOTE Timing measurements are referenced to and from a low voltage of 0.8 volts and a high voltage of 2.0 volts, unless otherwise noted

CRTC TIMING CHARACTERISTICS (Reference Figures 5 and 6)

| Characteristic | Symbol | Min | Max | Unit |
|--------------------------------------|-----------------------------------|-----|-----|------|
| Minimum Clock Pulse Width, Low | PWCL | 160 | - | ns |
| Minimum Clock Pulse Width, High | PWCH | 200 | _ | ns |
| Clock Frequency | f _c | 1 - | 25 | MHz |
| Rise and Fall Time for Clock Input | t _{cr} , t _{cf} | T - | 20 | ns |
| Memory Address Delay Time | tmAD. | - | 160 | ns |
| Raster Address Delay Time | tRAD | - | 160 | ns |
| Display Timing Delay Time | tDTD | - | 300 | ns |
| Horizontal Sync Delay Time | tHSD | - | 300 | ns |
| Vertical Sync Delay Time | tvsp | - | 300 | ns |
| Cursor Display Timing Delay Time | tCDD | - | 300 | ns |
| Light Pen Strobe Minimum Pulse Width | PWLPH | 100 | _ | ns |
| Light Pen Strobe Disable Time | tLPD1 | - | 120 | ns |
| | tLPD2 | T - | 0 | ns |

NOTE The light pen strobe must fall to low level before VS pulse rises

$MC6845 \bullet MC6845 \star 1 \bullet MC68A45 \bullet MC68A45 \star 1 \bullet MC68B45 \bullet MC68B45 \star 1$

CRTC INTERFACE SYSTEM DESCRIPTION

The CRT controller generates the signals necessary to interface a digital system to a raster scan CRT display. In this type of display, an electron beam starts in the upper left hand corner, moves quickly across the screen and returns. This action is called a horizontal scan After each horizontal scan the beam is incrementally moved down in the vertical direction until it has reached the bottom. At this point one frame has been displayed, as the beam has made many horizontal scans and one vertical scan.

Two types of raster scanning are used in CRTs, interlace and non-interlace, shown in Figures 7 and 8. Non-interlace scanning consists of one field per frame. The scan lines in Figure 7 are shown as solid lines and the retrace patterns are indicated by the dotted lines. Increasing the number of frames per second will decrease the flicker. Ordinarily, either a 50 or 60 frame per second refresh rate is used to minimize beating between the CRT and the power line frequency. This prevents the displayed data from weaving.

Interlace scanning is used in broadcast TV and on data monitors where high density or high resolution data must be displayed. Two fields, or vertical scans are made down the screen for each single picture or frame. The first field (even field) starts in the upper left hand corner; the second (odd field) in the upper center. Both fields overlap as shown in Figure 8, thus interlacing the two fields into a single frame.

In order to display the characters on the CRT screen the frames must be continually repeated. The data to be displayed is stored in the refresh (screen) memory by the MPU controlling the data processing system. The data is usually written in ASCII code, so it cannot be directly displayed as characters. A character generator ROM is typically used to convert the ASCII codes into the "dot" pattern for every character.

The most common method of generating characters is to create a matrix of dots "x" dots (columns) wide and "y" dots (rows) high Each character is created by selectively filling in the dots As "x" and "y" get larger a more detailed character may be created. Two common dot matrices are 5×7 and 7×9 Many variations of these standards will allow Chinese, Japanese, or Arabic letters instead of English. Since characters require some space between them, a character block larger than the character is typically used, as shown in Figure 9. The figure also shows the corresponding timing and levels for a video signal that would generate the characters.

Referring to Figure 2, the CRT controller generates the refresh addresses (MA0-MA13), row addresses (RA0-RA4),

and the video timing (vertical sync - VS, horizontal sync - HS, and display enable - DE) Other functions include an internal cursor register which generates a cursor output when its contents compare to the current refresh address A light pen strobe input signal allows capture of the refresh address in an internal light pen register.

All timing in the CRTC is derived from the CLK input. In alphanumeric terminals, this signal is the character rate. The video rate or "dot" clock is externally divided by high-speed logic (TTL) to generate the CLK input. In alphanumeric terminals, this signal is the character rate. The video rate or "dot" clock is externally divided by high-speed logic (TTL) to generate the CLK signal. The high-speed logic must also generate the timing and control signals necessary for the shift register, latch, and MUX control.

The processor communicates with the CRTC through an 8-bit data bus by reading or writing into the 19 registers

The refresh memory address is multiplexed between the processor and the CRTC. Data appears on a secondary bus separate from the processor's bus. The secondary data bus concept in no way precludes using the refresh RAM for other purposes. It looks like any other RAM to the processor. A number of approaches are possible for solving contentions for the refresh memory.

- 1 Processor always gets priority (Generally, "hash" occurs as MPU and CRTC clocks are not synchronized.)
- 2 Processor gets priority access anytime, but can be synchronized by an interrupt to perform accesses only during horizontal and vertical retrace times
- Synchronize the processor with memory wait cycles (states)
- 4 Synchronize the processor to the character rate as shown in Figure 10 The M6800 processor family works very well in this configuration as constant cycle lengths are present This method provides no overhead for the processor as there is never a contention for a memory access. All accesses are transparent.

The present version of the CRTC is being upgraded to improve functionality. This data sheet contains the information describing both the MC6845 (present CRTC) and the MC6845 \(\times 1 \) (upgraded CRTC) Complete compatibility between both versions is maintained by programming all register bits, which are undefined/unused, in the MC6845 with zero's

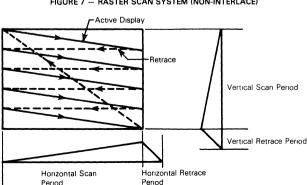


FIGURE 7 - RASTER SCAN SYSTEM (NON-INTERLACE)

FIGURE 8 - RASTER SCAN SYSTEM (INTERLACE)

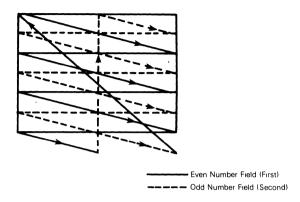


FIGURE 9 - CHARACTER DISPLAY ON THE SCREEN AND VIDEO SIGNAL

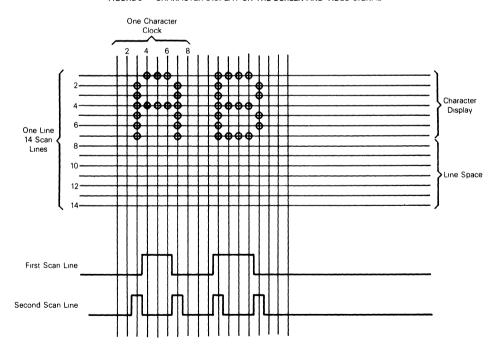
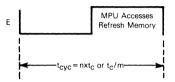


FIGURE 10 — TRANSPARENT REFRESH MEMORY CONFIGURATION TIMING USING M6800 FAMILY MPU





Where m, n are integers, to is character period

TABLE 1 - CRTC OPERATING MODE

| RESET | LPSTB | Operating Mode | | |
|-------|-------|----------------|--|--|
| 0 | 0 0 | | | |
| 0 | 1 | Test Mode | | |
| 1 | 0 | Normal Mode | | |
| 1 | 1 | Normal Mode | | |

The test mode configures the memory addresses as two independent 7-bit counters to minimize test time

PIN DESCRIPTION

PROCESSOR INTERFACE

The CRTC interfaces to a processor bus on the bidirectional data bus (D0-D7) using \overline{CS} , RS, E, and R/ \overline{W} for control signals

Data Bus (D0-D7) — The bidirectional data lines (D0-D7) allow data transfers between the internal CRTC register file and the processor Data bus output drivers are high-impedance state until the processor performs a CRTC read operation.

Enable (E) — The Enable signal is a high-impedance TTL/MOS compatible input which enables the data bus input/output buffers and clocks data to and from the CRTC This signal is usually derived from the processor clock. The high-to-low transition is the active edge

Chip Select (CS) — The CS line is a high-impedance TTL/MOS compatible input which selects the CRTC, when low, to read or write to the internal register file. This signal should only be active when there is a valid stable address being decoded from the processor.

Register Select (RS) — The RS line is a high-impedance TTL/MOS compatible input which selects either the address register (RS = "0") or one of the data register (RS = "1") or the internal register file

Read/Write (R/\overline{W}) — The R/\overline{W} line is a high-impedance TTL/MOS compatible input which determines whether the internal register file gets written or read. A write is defined as a low level

CRT CONTROL

The CRTC provides horizontal sync (HS), vertical sync (VS), and display enable (DE) signals

NOTE

Care should be exercised when interfacing to CRT monitors, as many monitors claiming to be "TTL compatible" have transistor input circuits which require the CRTC or TTL devices buffering signals from the CRTC/video circuits to exceed the maximum-rated drive currents

Vertical Sync (VS) and Horizontal Sync (HS) — These TTL-compatible outputs are active high signals which drive the monitor directly or are fed to the video processing circuitry to generate a composite video signal. The VS signal determines the vertical position of the displayed text while the HS signal determines the horizontal position of the displayed text.

Display Enable (DE) — This TTL-compatible output is an active high signal which indicates the CRTC is providing addressing in the active display area

REFRESH MEMORY/CHARACTER GENERATOR ADDRESSING

The CRTC provides memory addresses (MA0-MA13) to scan the refresh RAM. Row addresses (RA0-RA4) are also provided for use with character generator ROMs. In a graphics system, both the memory addresses and the row addresses would be used to scan the refresh RAM. Both the memory addresses and the row addresses continue to run during vertical retrace thus allowing the CRTC to provide the refresh addresses required to refresh dynamic RAMs.

Refresh Memory Addresses (MA0-MA13) — These 14 outputs are used to refresh the CRT screen with pages of data located within a 16K block of refresh memory. These outputs are capable of driving one standard TTL load and 30 pF

Row Addresses (RA0-RA4) — These five outputs from the internal row address counter are used to address the character generator ROM. These outputs are capable of driving one standard TTL load and 30 pF.

OTHER PINS

Cursor — This TTL-compatible output indicates a valid cursor address to external video processing logic. It is an active high signal

Clock (CLK) — The CLK is a TTL/MOS-compatible input used to synchronize all CRT functions except for the processor interface An external dot counter is used to derive this signal which is usually the character rate in an alphanumeric CRT The active transition is high-to-low

Light Pen Strobe (LPSTB) — A low-to-high transition on this high-impedance TTL/MOS-compatible input latches the current Refresh Address in the light pen register. The latching of the refresh address is internally synchronized to the character clock (CLK).

V_{CC}, **V_{SS}** - These inputs supply +5 Vdc $\pm5\%$ to the CRTC.

RESET — The RESET input is used to reset the CRTC. A low level on the RESET input forces the CRTC into the following state

- (a) All counters in the CRTC are cleared and the device stops the display operation
- (b) All the outputs are driven low

(c) The control registers of the CRTC are not affected and remain unchanged

Functionality of RESET differs from that of other M6800 parts in the following functions

- (a) The RESET input and the LPSTB input are encoded as shown in Table 1
- (b) After RESET has gone low and (LPSTB = "0"), MA0-MA13 and RA0-RA4 will be driven low on the falling edge of CLK RESET must remain low for at least one cycle of the character clock (CLK)
- (c) The CRTC resumes the display operation immediately after the release of RESET DE is not active until after the first VS pulse occurs

CRTC DESCRIPTION (Figure 11 CRTC Block Diagram)

The CRTC consists of programmable horizontal and vertical timing generators, programmable linear address register, programmable cursor logic, light pen capture register, and control circuitry for interface to a processor bus

All CRTC timing is derived from CLK, usually the output of an external dot rate counter. Coincidence (CO) circuits continuously compare counter contents to the contents of the programmable register file, R0-R17. For horizontal timing generation, comparisons result in 1) horizontal sync pulse (HS) of a frequency, position, and width determined by the registers, 2) horizontal display signal of a frequency, position, and duration determined by the registers.

The horizontal counter produces H clock which drives the scan line counter and vertical control. The contents of the Raster Counter are continuously compared to the maximum scan line address register. A coincidence resets the raster counter and clocks the vertical counter.

Comparisons of vertical counter contents and vertical registers result in 1) vertical sync pulse (VS) of a frequency, width and position determined by the registers, 2) vertical display of a frequency and position determined by the registers

The vertical control logic has other functions

- 1 Generate row selects, RA0-RA4, from the raster count for the corresponding interlace or non-interlace modes
- 2 Extend the number of scan lines in the vertical total by the amount programmed in the vertical total adjust register.

The linear address generator is driven by CLK and locates the relative positions of characters in memory with their positions on the screen. Fourteen lines, MA0-MA13, are available for addressing up to four pages of 4K characters, 8 pages of 2K characters, etc. Using the start address register, hardware scrolling through 16K characters is possible. The linear address generator repeates the same sequence of addresses for each scan line of a character row.

The cursor logic determines the cursor location, size, and blink rate on the screen. All are programmable

The light pen strobe going high causes the current contents of the address counter to be latched in the light pen

register. The contents of the light pen register are subsequently read by the processor

Internal CRTC registers are programmed by the processor through the data bus, D0-D7, and the control signals $-R/\overline{W}$, \overline{CS} , RS, and E

REGISTER FILE DESCRIPTIONS

The nineteen registers of the CRTC may be accessed through the data bus Only two memory locations are required as one location is used as a pointer to address one of the remaining eighteen registers. These eighteen registers control horizontal timing, vertical timing, interlace operation, row address operation, and define the cursor, cursor address, start address, and light pen register. The register addresses and sizes are shown in Table 2.

ADDRESS REGISTER

The address register is a 5-bit write-only register used as an "indirect" or "pointer" register. It contains the address of one of the other eighteen registers. When both RS and $\overline{\text{CS}}$ are low, the address register is selected. When $\overline{\text{CS}}$ is low and RS is high, the register pointed to by the address register is selected.

TIMING REGISTERS RO-R9

Figure 12 shows the visible display area of a typical CRT monitor giving the point of reference for horizontal registers as the left most displayed character position. Horizontal registers are programmed in character clock time units with respect to the reference as shown in Figure 13. The point of reference for the vertical registers is the top character position displayed. Vertical registers are programmed in scan line times with respect to the reference as shown in Figure 14.

Horizontal Total Register (R0) — This 8-bit write-only register determines the horizontal sync (HS) frequency by defining the HS period in character times. It is the total of the displayed characters plus the non-displayed character times (retrace) minus one

R/W CS RS E RESET DO-D7 VCC GND *** * * *** Address Register СО and Decoder Horizontal CLK-CTR (-256) Horizontal Total со MC H Display forizontal Displaye Reg СО Horizontal HS Sync Position Reg Sync Width СО CTR (-16) **→**HS Ŭ Horizontal Sync Width Register СО Character Row CTR (- 128) со Vertical Total Reg Vertical Total Adjust Register V Display Control со нн-Reg Position Reg **→** vs Interlace Mode Reg Scan Line CTR (-32) MC со Address Reg Cursor **→**CURSOR Hend-Address Generator Cursor Address Reg СО Light Pen Reg Sync -LPSTB RA0-RA4 MA0-MA13

FIGURE 11 — CRTC BLOCK DIAGRAM

TABLE 2 — CRTC INTERNAL REGISTER ASSIGNMENT (Features of the MC6845-1 have 1 subscript)

| cs | RS | 1 | Addre | ss Re | giste | r | Register | er Register File Prog | | Read | Write | | | N | umber | of B | its | | |
|----|----|---|-------|-------|-------|---|----------|-------------------------|-----------|------|-------|----------------|----------------|----------------|----------------|------|-----|--------|----|
| CS | no | 4 | 3 | 2 | 1 | 0 | # | negister rile | Unit | neau | AALIE | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| 1 | Х | X | Х | Х | Х | Х | X | _ | _ | - | _ | | | / | | | | / | |
| 0 | 0 | X | Х | Х | X | X | AR | Address Register | - | No | Yes | | | | | | | | |
| 0 | 1 | 0 | 0 | 0 | 0 | 0 | R0 | Horizontal Total | Char | No | Yes | | | | | | | | |
| 0 | 1 | 0 | 0 | 0 | 0 | 1 | R1 | Horizontal Displayed | Char | No | Yes | | | | | | | | |
| 0 | 1 | 0 | 0 | 0 | 1 | 0 | R2 | H Sync Position | Char | No | Yes | | | | | | | | |
| 0 | 1 | 0 | 0 | 0 | 1 | 1 | R3 | Sync Width | _ | No | Yes | V ₁ | ٧1 | V ₁ | V ₁ | Н | Н | Н | Н |
| 0 | 1 | 0 | 0 | 1 | 0 | 0 | R4 | Vertical Total | Char Row | No | Yes | | | | | | | | |
| 0 | 1 | 0 | 0 | 1 | 0 | 1 | R5 | V Total Adjust | Scan Line | No | Yes | | | | | | | | |
| 0 | 1 | 0 | 0 | 1 | 1 | 0 | R6 | Vertical Displayed | Char Row | No | Yes | | | | | | | | |
| 0 | 1 | 0 | 0 | 1 | 1 | 1 | R7 | V Sync Position | Char Row | No | Yes | | | | | | | | |
| 0 | 1 | 0 | 1 | 0 | 0 | 0 | R8 | Interlace Mode and Skew | Note 1 | No | Yes | C ₁ | C ₁ | D ₁ | D ₁ | | | 1 | 1 |
| 0 | 1 | 0 | 1 | 0 | 0 | 1 | R9 | Max Scan Line Address | Scan Line | No | Yes | | | | | | | | |
| 0 | 1 | 0 | 1 | 0 | 1 | 0 | R10 | Cursor Start | Scan Line | No | Yes | | В | Р | | | () | lote 2 | 2) |
| 0 | 1 | 0 | 1 | 0 | 1 | 1 | R11 | Cursor End | Scan Line | No | Yes | | | | | | | | |
| 0 | 1 | 0 | 1 | 1 | 0 | 0 | R12 | Start Address (H) | _ | Yes | Yes | 0 | 0 | | | | | | |
| 0 | 1 | 0 | 1 | 1 | 0 | 1 | R13 | Start Address (L) | _ | Yes | Yes | | | | | | | | |
| 0 | 1 | 0 | 1 | 1 | 1 | 0 | R14 | Cursor (H) | _ | Yes | Yes | 0 | 0 | | | | | | |
| 0 | 1 | 0 | 1 | 1 | 1 | 1 | R15 | Cursor (L) | _ | Yes | Yes | | | | | | | | |
| 0 | 1 | 1 | 0 | 0 | 0 | 0 | R16 | Light Pen (H) | _ | Yes | No | 0 | 0 | | | | | | |
| 0 | 1 | 1 | 0 | 0 | 0 | 1 | R17 | Light Pen (L) | - | Yes | No | | | | | | | | |

NOTES

- 1 The skew control is shown in Table 3 and interlace is shown in Table 4
- 2. Bit 5 of the Cursor Start Raster Register is used for blink period control, and Bit 6 is used to select blink or non-blink

Number of Horizontal Total Char (Nht+1)

Number of Horizontal Displayed Char (Nhtd)

ABC

Number of Horizontal Displayed Char (Nhtd)

Number of Nettcal Displayed Char (Nhtd)

Display Period

Vertical Retrace Period

FIGURE 12 - ILLUSTRATION OF THE CRT SCREEN FORMAT

Note 1 Timing values are described in Table 8

Total Scan Line Adjust (Nadj) -

Horizontal Displayed Register (R1) — This 8-bit write-only register determines the number of displayed characters per line. Any 8-bit number may be programmed as long as the contents of R0 are greater than the contents of R1

Horizontal Sync Position Register (R2) — This 8-bit write-only register controls the HS position. The horizontal sync position defines the horizontal sync delay (Front Porch) and the horizontal scan delay (Back Porch) When the programmed value of this register is increased, the display on the CRT screen is shifted to the left. When the programmed value is decreased the display is shifted to the right Any 8-bit number may be programmed as long as the sum of the contents of R1, R2, and R3 are less than the contents of R0

Sync Width Register (R3) — This 8-bit write-only register determines the width of the vertical sync (VS) pulse and the horizontal sync (HS) pulse for the MC6845 \pm 1 CRTC. The vertical sync pulse width is fixed at 16 scan-line times for the MC6845 and the upper four bits of this register are treated as "don't cares."

The MC6845 ★ 1 allows control of the VS pulse width for 1-to-16 scan-line times. Programming the upper four bits for 1-to-15 will select pulse widths from 1-to-15 scan-line times Programming the upper four bits as zeros will select a VS pulse width of 16 scan-line times, allowing compatibility with the MC6845.

For both the MC6845 and the MC6845 \$\darkingeq 1\$, the HS pulse width may be programmed from 1-to-15 character clock periods thus allowing compatibility with the HS pulse width specifications of many different monitors. If zero is written into this register then no HS is provided.

Horizontal Timing Summary (Figure 13) — The difference between R0 and R1 is the horizontal blanking interval. This interval in the horizontal scan period allows the beam to return (retrace) to the left side of the screen. The retrace time is determined by the monitor's horizontal scan components. Retrace time is less than the horizontal blanking interval. A good rule of thumb is to make the horizontal blanking about 20% of the total horizontal scanning period for a CRT. In inexpensive TV receivers, the beam overscans the display screen so that aging of parts does not result in underscanning. Because of this, the retrace time should be about ½ the horizontal scanning period. The horizontal sync delay, HS pulse width, and horizontal scan delay are typically programmed with a 1·2 2 ratio.

Vertical Total Register (R4) and Vertical Total Adjust Register (R5) — The frequency of VS is determined by both R4 and R5. The calculated number of character line times is usually an integer plus a fraction to get exactly a 50 or 60 Hz vertical refresh rate. The integer number of character line times minus one is programmed in the 7-bit write-only vertical total register (R4). The fraction of character line times is programmed in the 5-bit write-only vertical total adjust register (R5) as a number of scan-line times.

Vertical Displayed Register (R6) — This 7-bit write-only register specifies the number of displayed character rows on the CRT screen, and is programmed in character row times Any number smaller than the contents of R4 may be programmed into R6.

Vertical Sync Position (R7) — This 7-bit write-only register controls the position of vertical sync with respect to the reference. It is programmed in character row times. The

value programmed in the register is one less than the number of computed character-line times. When the programmed value of this register is increased, the display position of the CRT screen is shifted up. When the programmed value is decreased the display position is shifted down. Any number equal to or less than the vertical total (R4) may be used

Interlace Mode and Skew Register (R8) — The MC6845 only allows control of the interlace modes as programmed by the low order two bits of this write-only register. The MC6845-1 controls the interlace modes and allows a programmable delay of zero-to-two character clock times for the DE (display enable) and cursor outputs. Table 3 describes operation of the cursor and DE skew bits. Cursor skew is controlled by bits 6 and 7 of R8 while DE skew is controlled by bits 4 and 5. Table 4 shows the interlace modes available to the user. These modes are selected using the two low order bits of this 6-bit write-only register.

In the normal sync mode (non-interlace) only one field is available as shown in Figures 7 and 15a. Each scan line is refreshed at the VS frequency (e.g., 50 or 60 Hz).

Two interlace modes are available as shown in Figures 8, 15b, and 15c. The frame time is divided between even and odd alternating fields. The horizontal and vertical timing relationship (VS delayed by ½ scan line time) results in the displacement of scan lines in the odd field with respect to the even field.

In the interlace sync mode the same information is painted in both fields as shown in Figure 15b. This is a useful mode for filling in a character to enhance readability

In the interlace sync and video mode, shown in Figure 15c, alternating lines of the character are displayed in the even field and the odd field. This effectively doubles the given bandwidth of the CRT monitor

Care must be taken when using either interlace mode to avoid an apparent flicker effect. This flicker effect is due to the doubling of the refresh time for all scan lines since each field is displayed alternately and may be minimized with proper monitor design (e.g., longer persistence phosphors)

In addition, there are restrictions on the programming of the CRTC registers for interlace operation

1 For the MC6845

- The horizontal total register value, R0, must be odd (i.e., an even number of character times).
- b For interlace sync and video mode only, the maximum scan-line address, R9, must be odd (i e , an even number of scan lines).
- c For interlace sync and video mode only, the vertical displayed register (R6) must be even The programmed number Nvd, must be ½ the actual number required. The even numbered scan lines are displayed in the even field and the odd numbered scan lines are displayed in the odd field.
- d For interlace sync and video mode only, the cursor start register (R10) and cursor end register (R11) must both be even or both odd depending on which field the cursor is to be displayed in

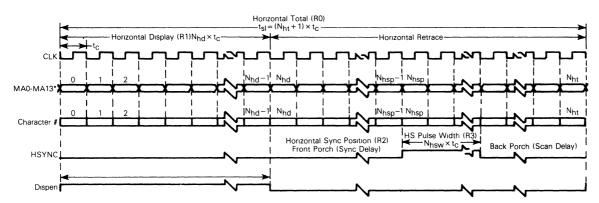
2 For the MC6845 ☆ 1.

- a The horizontal total register value, R0, must be odd (i.e., an even number of character times)
- For the interlace sync and video mode only, the vertical displayed register (R6) must be even. The programmed number, Nvd, must be ½ the actual number required

TABLE 3 - CURSOR AND DE SKEW CONTROL

| Value | Skew | |
|----------------------|--------------------|--|
| 00 No Character Skew | | |
| 01 | One Character Skew | |
| 10 | Two Character Skew | |
| 11 | Not Available | |

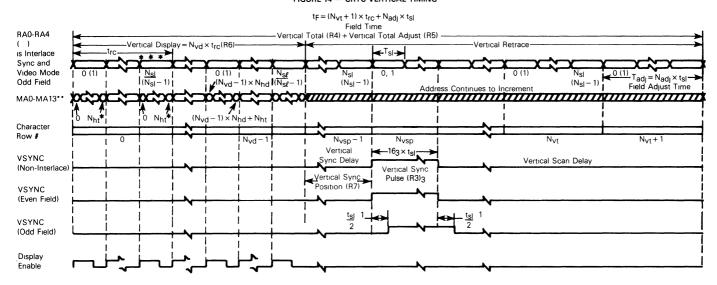
FIGURE 13 — CRTC HORIZONTAL TIMING



^{*}Timing is shown for first displayed scan row only See Chart in Figure 16 for other rows. The initial MA is determined by the contents of Start Address Register, R12/R13. Timing is shown for R12/R13=0.

Note 1 Timing values are described in Table 8

FIGURE 14 - CRTC VERTICAL TIMING



- *Nht must be an odd number for both interlace modes
 **Initial MA is determined by R12/R13 (Start Address Register), which is zero in this timing example
- ***N_{SI} must be an odd number for Interlace Sync and Video Mode

NOTES

- 1 Refer to Figure 8 The Odd Field is offset ½ horizontal scan time
- 2 Timing values are described in Table 8
- 3 Vertical Sync Pulse width may be programmed from 1 to 16 scan line times for the MC6845 ★1

TABLE 4 - INTERLACE MODE REGISTER

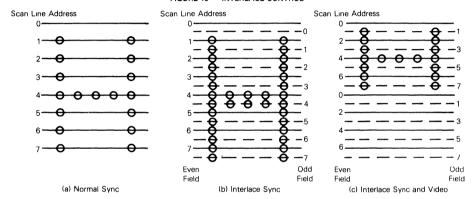
| Bit 1 | Bit 0 | Mode | | | | |
|-------|-------|--|--|--|--|--|
| 0 | 0 | No see Communication of the Co | | | | |
| 1 | 0 | Normal Sync Mode (Non-Interlac | | | | |
| 0 | 1 | Interlace Sync Mode | | | | |
| 1 | 1 | Interlace Sync and Video Mode | | | | |

TABLE 5 - CURSOR START REGISTER

| Bit 6 | Bit 5 | Cursor Display Mode |
|-------|-------|------------------------|
| 0 | 0 | Non-Blink |
| 0 | 1 | Cursor Non-Display |
| 1 | 0 | Blink, 1/16 Field Rate |
| 1 | 1 | Blink, 1/32 Field Rate |

Example of Cursor Display Mode

FIGURE 15 - INTERLACE CONTROL



Maximum Scan Line Address Register (R9) — This 5-bit write-only register determines the number of scan lines per character row including the spacing, thus, controlling operation of the row address counter. The programmed value is a maximum address and is one less than the number of scan lines.

CURSOR CONTROL

Cursor Start Register (R10) and Cursor End Reigster (R11) — These registers allow a cursor of up to 32 scan lines in height to be placed on any scan line of the character block as shown in Figure 16 R10 is a 7-bit write-only register used to define the start scan line and the cursor blink rate Bits 5 and 6 of the cursor start address register control the cursor operation as shown in Table 5 Non-display, display, and two blink modes (16 times or 32 times the field period) are available R11 is a 5-bit write-only register which defines the last scan line of the cursor

When an external blink feature on characters is required, it may be necessary to perform cursor blink externally so that both blink rates are synchronized. Note that an invert/non-invert cursor is easily implemented by programming the CRTC for a blinking cursor and externally inverting the video signal with an exclusive-OR gate.

Cursor Register (R14-H, R15-L) — This 14-bit read/write register pair is programmed to position the cursor anywhere in the refresh RAM area, thus, allowing hardware paging and scrolling through memory without loss of the original cursor position. It consists of an 8-bit low order (MA0 MA7) register and a 6-bit high order (MA8-MA13) register.

OTHER REGISTERS

Start Address Register (R12-H, R13-L) - This 14-bit write-only register pair controls the first address output by

the CRTC after vertical blanking. It consists of an 8-bit low order (MA0-MA7) register and a 6-bit high order (MA8-MA13) register. The start address register determines which portion of the refresh RAM is displayed on the CRT screen Hardware scrolling by character, line, or page may be accomplished by modifying the contents of this register.

Light Pen Register (R16-H, R17-L) — This 14-bit read-only register pair captures the refresh address output by the CRTC on the positive edge of a pulse input to the LPSTB pin It consists of an 8-bit low order (MA0-MA7) register and a 6-bit high order (MA8-MA13) register. Since the light pen pulse is asynchronous with respect to refresh address timing an internal synchronizer is designed into the CRTC. Due to delays (Figure 3) in this circuit, the value of R16 and R17 will need to be corrected in software. Figure 17 shows an interrupt driven approach although a polling routine could be used.

CRTC INITIALIZATION

Registers R0-R15 must be initialized after the system is powered up. The processor will normally load the CRTC register file from a firmware table. The worksheet of Table 6 is extremely useful in computing proper register values for the CRTC. Table 7 shows the worksheet filled out for an 80 × 24 configuration using a 7 × 9 character generator and Figure 18 shows an M6800 program which could be used to program the CRT controller. The programmed values allow use of either an MC6845 or MC6845 \$\pp\$1 CRTC.

The CRTC registers will have an initial value at power up When using a direct drive monitor (sans horizontal oscillator) these initial values may result in out-of-tolerance operation CRTC programming should be done immediately after power up especially in this type of system

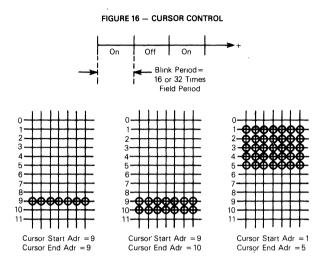
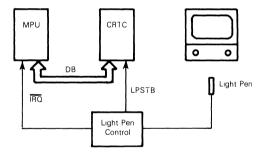


FIGURE 17 - INTERFACING OF LIGHT PEN



MC6845•MC6845 * 1•MC68A45•MC68A45 * 1•MC68B45•MC68B45 * 1

FIGURE 18 - MC6800 PROGRAM FOR CRTC INITIALIZATION

PAGE 001 CRTCINIT.SA:0 MC6845 / MC6845-1 CRTC initialization program

| 00001 00002 00003 00004 00005 00006 00007 00008 00009 | | | 9000 9001 | | * Assignment Assignmen | n CRTC EQU EQU | G,S,LLE=8 ******* addresses \$9000 CKTCAD+1 ******* | Address Register Data Register ******** |
|---|-------|-----|--------------|---------|--|----------------------|---|---|
| 00010 00011 | | | | | * Initi | alizat: | ion progra | am |
| 00011 00012A | 0000 | | | | | ORG | 0 | a place to start |
| 00013A | | 5F | | | | CLRB | | clear counter |
| 00014A | 0001 | CE | 1020 | Α | | LDX | #CRTTAB | table pointer |
| 00015A | 0004 | F7 | 9000 | A | CRTC1 | STAB | CRICAD | load address register |
| 00016A | | | | A | | LDAA | 0,X | get register value from table |
| 00017A | | | 9001 | A | | STAA | CRTCRG | program register |
| 00018A | | | | | | INX | | increment counters |
| 00019A | | | 10 | | | INCB | ¢10 | Einiche 32 |
| 00020A 00021A | | | | Ą ∧∧ | | CMPB | \$10 CRTC1 | finished? no: take branch |
| 00021A | | | 62 00 | 04 | | BNE SWT | CRICI | yes: call monitor |
| 00022A | 0012 | Jι | | | ***** | | ***** | ******************* |
| 00024 | | | | | * CRIC | regist | er initia | lization table |
| 00025 | | | | | * | | | |
| 00026A | 1020 | | | | | ORG | \$1020 | start of table |
| 00027A | 1020 | | 65 | Α | CRITAB | FCB | \$65,\$50 | RO, Rl - H total & H displayed |
| Α | 1021 | | 50 | Ą | | | | |
| 00028A | 1022 | | 56 | A | | FCB | \$56,\$09 | R2, R3 - HS pos. & HS width |
| | 1023 | | 09 | A | | | | |
| 00029A | | | 18 | A | - | FCB | \$18,\$0A | R4, R5 - V total & V total adj. |
| | 1025 | | 0A | A | | ECD | ¢10 ¢10 | DC D7 U displayed C UC pos |
| 00030A | | | 18 | P | - | FCB | \$18,\$18 | R6, R7 - V displayed \$ VS pos. |
| 00031A | 1027 | | 18 00 | P | - | FCB | \$00,\$0B | R8, R9 - Interlace & Max scan line |
| | 1029 | | 0B | 7 | - | I CD | \$00 , \$00 | 10, 19 - Interface a max scan line |
| 00032A | | | 00 | 7 | | FCB | \$00,\$0B | RlO,Rll - Cursor start & end |
| | 1028 | | 0B | į. | - | 1 0,5 | 400,403 | Tabylar Garbor Start a Sila |
| 00033A | 102C | | 0800 | 7 | A | FDB | \$0080 | Rl2,Rl3 - Start Address |
| 00034A | 102E | | 0080 | 7 | 4 | FDB | \$0080 | R14,R15 - Cursor Address |
| 00035 | | | | | | END | | |
| TOTAL | ERROR | S 0 | 0000 | -00 | 0000 | | | |

CRTCl 0004 CRTCAD 9000 CRTCRG 9001 CRTTAB 1020

TABLE 6 - CRTC FORMAT WORKSHEET

Display Format Worksheet

17 Dot Clock Rate (Line 4a × 16)

CRTC Registers

| 1 | Displayed Characters per Row | | Char | | | Decimal | Hex |
|----|---|------|------------|------------------|---------------------------------------|---------|-----|
| 2 | Displayed Character Rows per Screen | | Rows | RO Horizo | ontal Total (Line 15 – 1) | | |
| 3 | Character Matrix a Columns | | Columns | | ontal Displayed (Line 1) | | |
| | b Rows | | Rows | | ontal Sync Position (Line 1+ Line 12) | | |
| 4 | Character Block a Columns | | Columns | | ontal Sync Width (Line 13) | | |
| | b Rows | | Rows | | al Total (Line 9 – 1) | | |
| 5 | Frame Refresh Rate | | Hz | R5 Vertica | al Adjust (Line 9 Lines) | | |
| 6 | Horizontal Oscillator Frequency | | Hz | | al Displayed (Line 2) | | |
| 7 | Active Scan Lines (Line 2 × Line 4b) | | Lines | | al Sync Position (Line 2+ Line 10) | | |
| 8 | Total Scan Lines (Line 6 - Line 5) | | Lines | R8 Interla | ice (00 Normal, 01 Interlace, | | |
| 9 | Total Rows Per Screen (Line 8 – Line 4b) | Rows | and Lines | 03 lr | nterlace, and Video) | | |
| 10 | Vertical Sync Delay (Char Rows) | | Rows | R9 Max S | Scan Line Add (Line 4b – 1) | | |
| 11 | Vertical Sync Width (Scan Lines (16)) | 16 | Lines | R10 Cursor | r Start | | |
| 12 | Horizontal Sync Delay (Character Times) | | Char Times | R11 Cursor | r End . | | |
| 13 | Horizontal Sync Width (Character Times) | | Char Times | R12, R13 Start A | Address (H and L) | | |
| 14 | Horizontal Scan Delay (Character Times) | | Char Times | R14, R15 Cursor | r (H and L) | | |
| 15 | Total Character Times (Line 1 + 12 + 13 + 14) | | Char Times | | | | |
| 16 | Character Rate (Line 6 × 15) | | Hz | | | | |

TABLE 7 - WORKSHEET FOR 80 × 24 FORMAT

Display Format Worksheet

| 1 | Displayed Characters | per Row | 80 | Char |
|----|-------------------------|---------------------------|----------|-----------------|
| 2 | Displayed Character F | Rows per Screen | 24 | Rows |
| 3 | Character Matrix | a Columns | 7 | Columns |
| 4 | Character Block | b Rows a Columns | 9 | Rows Columns |
| | | b Rows | 11 | Rows |
| 5 | Frame Refresh Rate | | 60 | Hz |
| 6 | Horizontal Oscillator F | requency | 18,600 | Hz |
| 7 | Active Scan Lines (Li | ne 2× Line 4b) | 264 | Lines |
| 8 | Total Scan Lines (Line | e 6 – Line 5) | 310 | Lines |
| 9 | Total Rows Per Scree | en (Line 8 – Line 4b) | 28 Rows | and 2 Lines |
| 10 | Vertical Sync Delay (| Char Rows) | | Rows |
| 11 | Vertical Sync Width (| Scan Lines (16) | 16 | Lines |
| 12 | Horizontal Sync Delay | (Character Times) | 6 | Char Times |
| 13 | Horizontal Sync Widt | h (Character Times) | 99 | Char Times |
| 14 | Horizontal Scan Delay | (Character Times) | 7 | Char Times |
| 15 | Total Character Times | s (Line 1 + 12 + 13 + 14) | 102 | Char Times |
| 16 | Character Rate (Line | 6 times 15) | 1 8972 M | MHz |
| 17 | Dot Clock Rate (Line | 4a times 16) | 17 075 M | MHz |
| | | | | |

CRTC Registers

| | | Decimal | Hex |
|----------|--|---------|-----|
| RO | Horizontal Total (Line 15 minus 1) | 101 | 65 |
| R1 | Horizontal Displayed (Line 1) | 80 | 50 |
| R2 | Horizontal Sync Position (Line 1+ Line 12) | 86 | 56 |
| R3 | Horizontal Sync Width (Line 13) | 99 | 9 |
| R4 | Vertical Total (Line 9 minus 1) | 24 | 18 |
| R5 | Vertical Adjust (Line 9 Lines) | 10 | 0A |
| R6 | Vertical Displayed (Line 2) | 24 | 18 |
| R7 | Vertical Sync Position (Line 2+ Line 10) | 24 | 18 |
| R8 | Interlace (00 Normal, 01 Interlace, 03 Interlace, and Video) | | 0 |
| R9 | Max Scan Line Add (Line 4b minus 1) | 11 | B |
| R10 | Cursor Start | 0 | 0 |
| R11 | Cursor End | 11 | B |
| R12, R13 | Start Address (H and L) | 128 | 00 |
| | | | 80 |
| R14, R15 | Cursor (H and L) | 128 | 00 |
| | | | 80 |

OPERATION OF THE CRTC

TIMING CHART OF THE CRT INTERFACE SIGNALS

Timing charts of CRT interface signals are illustrated in this section with the aid of programmed example of the CRTC. When values listed in Table 8 are programmed into CRTC control registers, the device provides the outputs as shown in the timing diagrams (Figures 13, 14, 19, and 20). The screen format of this exmaple is shown in Figure 12 which illustrates the relation between refresh memory address (MA0-MA13), raster address (RA0-RA4), and the position on the screen. In this example, the start address is assumed to be "O".

ADDITIONAL CRTC APPLICATIONS

The foremost system function which may be performed by the CRTC controller is the refreshing of dynamic RAM. This

is quite simple as the refresh addresses continually run

Note that the LPSTB input may be used to support additional system functions other than a light pen. A digital-to-analog converter (DAC) and comparator could be configured to use the refresh addresses as a reference to a DAC composed of a resistive adder network connected to a comparator. The output of the comparator would generate the LPSTB input signifying a match between the refresh address analog level and the unknown voltage.

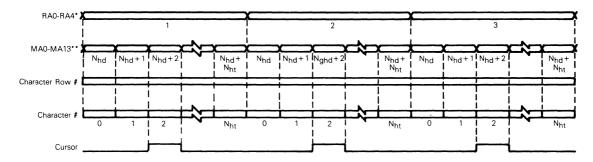
The light pen strobe input could also be used as a character strobe to allow the CRTC refresh addresses to decode a keyboard matrix. Debouncing would need to be done in software.

Both the VS and HS outputs may be used as a real-time clock. Once programmed, the CRTC will provide a stable reference frequency.

TABLE 8 - VALUES PROGRAMMED INTO CRTC REGISTERS

| Reg. # | Register Name | Value | Programmed Value |
|--------|-----------------------|--------------------|---------------------|
| R0 | H Total | N _{ht} +1 | N _{ht} |
| R1 | H Displayed | N _{hd} | N _{hd} |
| R2 | H Sync Position | N _{hsp} | N _{hsp} |
| R3 | H Sync Width | N _{hsw} | N _{hsw} |
| R4 | V Total | $N_{vt} + 1$ | N _{Vt} |
| R5 | V Scan Line Adjust | N _{adj} | N _{adj} |
| R6 | V Displayed | N _{vd} | N _{vd} |
| R7 | V Sync Position | N _{vsp} | N _{vsp} |
| R8 | Interlace Mode | | · |
| R9 | Max Scan Line Address | N _{sl} | N _{sl} |
| R10 | Cursor Start | 1 | |
| R11 | Cursor End | 3 | |
| R12 | Start Address (H) | 0 | |
| R13 | Start Address (L) | 0 | |
| R14 | Cursor (H) | 0 | |
| · R15 | Cursor (L) | 2 | |
| R16 | Light Pen (H) | | |
| R17 | Light Pen (L) | | |

FIGURE 19 — CURSOR TIMING



^{*}Timing is shown for non-interlace and interlace sync modes Example shown has cursor programmed as

Cursor Register = N_{hd} + 2

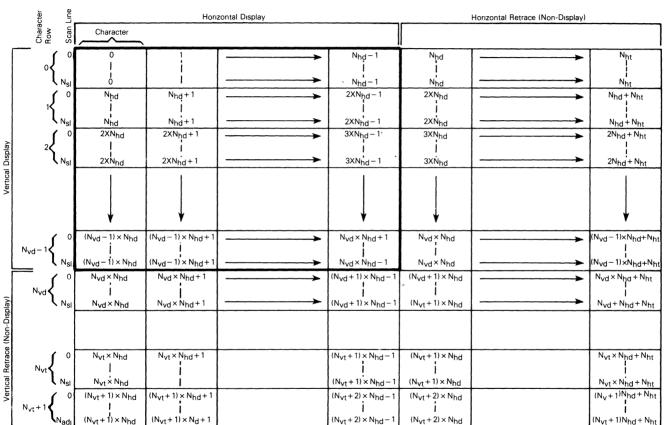
Cursor Start = 1

Cursor End = 3

**The initial MA is determined by the contents of Start Address Register, R12/R13 Timing is shown for R12/R13=0

Note 1 Timing values are described in Table 8

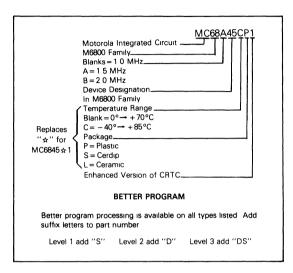
FIGURE 20 — REFRESH MEMORY ADDRESSING (MA0-MA13) STAGE CHART



NOTE 1 The initial MA is determined by the contents of start address register, R12/R13 Timing is shown for R12/R13=0 Only Non-Interlace and Interlace Sync Modes are shown

MC6845 • MC6845 * 1 • MC68A45 • MC68A45 * 1 • MC68B45 • MC68B45 * 1

ORDERING INFORMATION



Level 1 "S" = 10 Temp Cycles - (- 25 to 150°C), If Temp testing at T $_{\rm A}$ max Level 2 "D" = 168 Hour Burn-in at 125°C Level 3 "DS" = Combination of Level 1 and 2



MC6846 (1.0 MHz) MC68A46 (1.5 MHz)

ROM - I/O - TIMER

The MC6846 combination chip provides the means, in conjunction with the MC6802, to develop a basic 2-chip microcomputer system. The MC6846 consists of 2048 bytes of mask-programmable ROM, an 8-bit bidirectional data port with control lines, and a 16-bit programmable timer-counter.

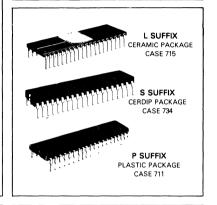
This device is capable of interfacing with the MC6802 (basic MC6800, clock, and 128 bytes of RAM) as well as the entire M6800 family if desired. No external logic is required to interface with most peripheral devices.

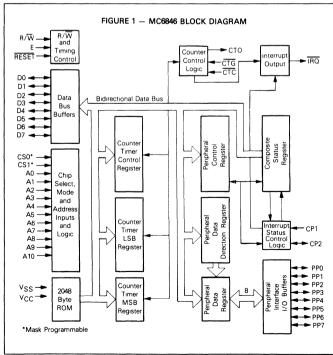
- 2048 8-Bit Bytes of Mask-Programmable ROM
- 8-Bit Bidirectional Data Port for Parallel Interface plus Two Control Lines
- Programmable Interval Timer-Counter Functions
- Programmable I/O Peripheral Data, Control, and Direction Registers
- Compatible with the Complete M6800 Microcomputer Product Family
- TTL-Compatible Data and Peripheral Lines
- Single 5-Volt Power Supply

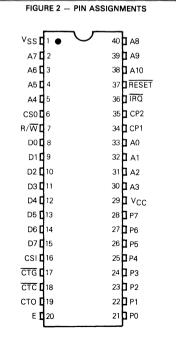
MOS

(N-CHANNEL, SILICON-GATE, DEPLETION LOAD)

ROM-I/O-TIMER







MAXIMUM RATINGS

| Rating | Symbol | Value | Unit |
|---|------------------|--|------|
| Supply Voltage | Vcc | -03 to +70 | ٧ |
| Input Voltage | V _{in} | -0.3 to $+7.0$ | ٧ |
| Operating Temperature Range MC6846, MC68A46 MC6846C, MC68A46C | TA | T _L to T _H 0 to +70 -40 to +85 | °C |
| Storage Temperature Range | T _{stg} | - 55 to + 150 | °C |

THERMAL CHARACTERISTICS

| Characteristic | Symbol | Value | Unit |
|---|--------|-----------------|------|
| Thermal Resistance Ceramic Plastic Cerdip | θJA | 50 100 60 | °C/W |

This device contains circuitry to protect the inputs against damage due to high static voltages or electric fields, however, it is advised that normal precautions be taken to avoid application of any voltage higher than maximum rated voltages to this high-impedance circuit. Reliability of operation is enhanced if unused inputs are tied to an appropriate logic voltage level (e.g., either VSS or VCC).

(2)

POWER CONSIDERATIONS

The average chip-junction temperature, TJ, in °C can be obtained from

$$T_{J} = T_{A} + (P_{D} \bullet \theta_{JA})$$
Where:

TA = Ambient Temperature, °C

θ J A ■ Package Thermal Resistance, Junction-to-Ambient, °C/W

PD ■ PINT + PPORT

 $P_{INT} = I_{CC} \times V_{CC}$, Watts - Chip Internal Power

PPORT = Port Power Dissipation, Watts — User Determined

For most applications PPORT ◀PINT and can be neglected PPORT may become significant if the device is configured to drive Darlington bases or sink LED loads

An approximate relationship between PD and TJ (if PPORT is neglected) is

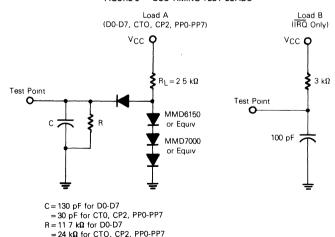
$$P_D = K - (T_J + 273 ^{\circ}C)$$

Solving equations 1 and 2 for K gives

$$K = P_{D} \bullet (T_{\Delta} + 273^{\circ}C) + \theta_{1}\Delta \bullet P_{D}^{2}$$

Where K is a constant pertaining to the particular part. K can be determined from equation 3 by measuring P_D (at equilibrium) for a known T_A . Using this value of K the values of P_D and T_J can be obtained by solving equations (1) and (2) iteratively for any value of T_A

FIGURE 3 - BUS TIMING TEST LOADS



ELECTRICAL CHARACTERISTICS (V_{CC}=5 0 V \pm 5%, V_{SS}=0, T_A=0 to 70°C unless otherwise noted)

| Characteristic | | Symbol | Min | Тур | Max | Unit |
|---|-----------------|------------------|--|------------------|--|----------|
| Input High Voltage All | Inputs | VIH | V _{SS} +20 | | VCC | V |
| Input Low Voltage All | Inputs | V _{IL} | V _{SS} -03 | - | V _{SS} +08 | ٧ |
| Clock Overshoot/Undershoot Input High Input Low | | Vos | V _{CC} -05 V _{SS} -05 | - | V _{CC} +05 V _{SS} +05 | ٧ |
| Input Leakage Current R/W, RESET, CSC (V _{In} = 0 to 5 25 V) CP1, CTG, CTC, E, A | | I _{in} | _ | 1 0 | 2 5 | μΑ |
| Three-State (Off State) Input Current (V _{In} = 0 4 to 2 4 V) PPO-PP | D0-D7 7, CP2 | ^I TSI | _ | 2 0 | 10 | μΑ |
| Output High Voltage | | | | | | |
| $(I_{Load} = -205 \mu\text{A})$ $(I_{Load} = -200 \mu\text{A})$ Other Or | D0-D7 utputs | Voн | V _{SS} +24 V _{SS} +24 | - | - | ٧ |
| Output Low Voltage (ILoad = 1 6 mA) (ILoad = 3 2 mA) Other Order | D0-D7 utputs | VOL | 1 | 1 1 | V _{SS} +04 V _{SS} +04 | ٧ |
| Output High Current (Sourcing) (VOH = 2 4 V) Other Or | D0-D7 utputs | ЮН | 205 200 | _ | | μΑ μΑ |
| $(V_O = 1.5 \text{ V}, \text{ the current for driving other than TTL}, e g , Darlington Base)$ CP2, PP | 0-PP7 | | -10 | _ | - 10 | mA |
| Output Low Current (Sinking) (VOL = 0 4 V) Other O | D0-D7 utputs | lor | 16 .32 | - | _ | mA |
| Output Leakage Current (Off State) (VOH = 2 4 V) | IRQ | loh | - | _ | 10 | μΑ |
| Internal Power Dissipation (Measured at T _A = 0 °C) | | PINT | _ | _ | 1000 | mW |
| Capacitance $(V_{IN}=0, T_{A}=25^{\circ}\text{C}, f=10\text{MHz})$ PP0-PP: A0-A10, R/ $\overline{\text{W}}$, RESET, CS0, CS1, CP1, CTC | | C _{in} | - - - | _ _ _ _ | 20 12 5 10 7 5 | pF |
| PPO-PP7, C | 2, CT0 | C _{out} | water or mo | - | 5 0 10 | рF |
| | C6846 68A46 | f | 0 1 0 1 | -, | 1 0 1 5 | MHz |
| Clock Timing Enable Cycle Time | | †cycE | 10 | _ | | μS |
| Reset Low Time | | tRL | 2 | _ | | μS |
| Interrupt Release | | tIR | | | 16 | μS |

I/O TIMING — Peripheral I/O Lines

| Characteristic | Symbo | Min Min | Max | Unit |
|--------------------------------------|-------------------|---------|-----|------|
| Peripheral Data Setup | tPDSU | 200 | | ns |
| Rise and Fall Times CP1, CP2 | tpr, tp | _ | 10 | μS |
| Delay Time E to CP2 Fall | ^t CP2 | | 1 0 | μS |
| Delay Time I/O Data CP2 Fall | , t _{DC} | 20 | | ns |
| Delay Time E to CP2 Rise | ^t RS1 | | 10 | μS |
| Delay Time CP1 to CP2 Rise | tRS2 | | 2 0 | μS |
| Peripheral Data Delay | ^t PDW | | 10 | μS |
| Peripheral Data Setup Time for Latch | t _{PDSU} | 100 | | ns |
| Peripheral Data Hold Time for Latch | tPDH | 15 | - | ns |

I/O TIMING — Timer-Counter Lines

| Input Rise and Fall Time | CTC and CTG | tCR, tCF | _ | 100 | ns |
|--|-------------|------------------|-------------------------|-----|----|
| Input Pulse Width High (Asynchronous Mode) | | ^t PWH | t _{cycE} + 250 | _ | ns |
| Input Pulse Width Low (Asynchronous Mode) | | t _{PWL} | t _{cycE} + 250 | - | ns |
| Input Setup Time (Synchronous Mode) | | t _{su} | 200 | | ns |
| Input Hold Time (Synchronous Mode) | | ^t hd | 50 | _ | ns |
| Output Delay | | [†] CTO | | 10 | μS |

BUS TIMING CHARACTERISTICS (See Notes 1 and 2)

| ldent Number | Characteristic | Symbol | MC6846 Min Max | | MC6 Min | 8A46 Max | Unit |
|-----------------|---------------------------------|---------------------------------|---------------------|------|------------|-------------|------|
| 1 | Cycle Time | t _{cyc} | 10 | 10 | 0 67 | 10 | μS |
| 2 | Pulse Width, E Low | PWEL | 430 | 9500 | 280 | 9500 | ns |
| 3 | Pulse Width, E High | PWEH | 450 | 9500 | 280 | 9500 | ns |
| 4 | Clock Rise and Fall Time | t _r , t _f | _ | 25 | _ | 25 | ns |
| 9 | Address Hold Time | tAH | 10 | - | 10 | - | ns |
| 13 | Address Setup Time Before E | tAS | 80 | - | 60 | - | ns |
| 14 | Chip Select Setup Time Before E | tcs | 80 | - | 60 | - | ns |
| 15 | Chip Select Hold Time | tCH | 10 | _ | 10 | - | ns |
| 18 | Read Data Hold Time | t _{DHR} | 20 | 100 | 20 | 100 | ns |
| 21 | Write Data Hold Time | tDHW | 10 | _ | 10 | - | ns |
| 30 | Output Data Delay Time | †DDR | _ | 290 | | 180 | ns |
| 31 | Input Data Setup Time | tDSW | 165 | | 80 | _ | ns |

NOTES

- 1 Voltage levels shown are V_L \leq 0 4 V, V_H \geq 2 4 V, unless otherwise specified 2 Measurement points shown are 0 8 V and 2 0 V unless otherwise specified

FIGURE 4 - BUS TIMING

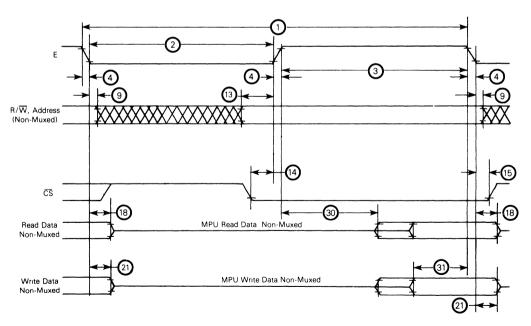


FIGURE 5 — PERIPHERAL PORT LATCH SETUP AND HOLD TIME

PPO-PP7

tpSU

tpDH

FIGURE 6 — PERIPHERAL DATA AND CP2 DELAY (Control Mode PCR5=1, PCR4=0, PCR3=1)

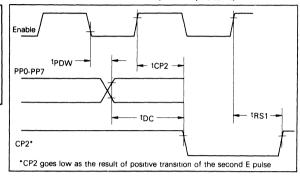
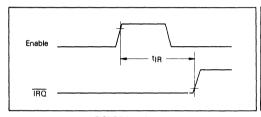


FIGURE 7- IRQ RELEASE TIME

FIGURE 8 - PERIPHERAL PORT SETUP TIME



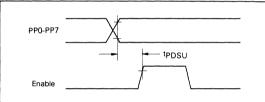


FIGURE 9 — CP2 DELAY TIME (PCR5=1, PCR4=0, PCR3=0)

FIGURE 10 - INPUT PULSE WIDTHS

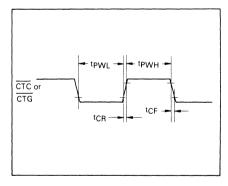


FIGURE 11 - INPUT SETUP AND HOLD TIMES*

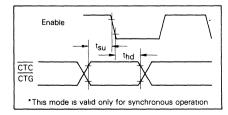
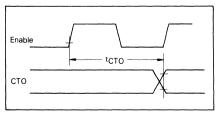


FIGURE 12 - OUTPUT DELAY



NOTE. Timing measurements are referenced to and from a low voltage of 0.8 volts and a high voltage of 2.0 volts unless otherwise noted

Vcc Vcc Vcc MC6846 Counter/ IRQ RESET Timer !/O ROM, I/O, TIMER MR VMA HALT RESET VMA Clock RF 2 k Bytes ROM R/W R/W 10 I/O Lines NMI 3 Lines Timer MC6802 Parallel I/C MPU RΔ D0-D7 D0-D7 D0-D7 EXta ΔO-Δ10 A0-A15 A0-A15 Control Xtal CS1

FIGURE 13 - TYPICAL MICROCOMPUTER

Figure 13 is a block diagram of a typical cost-effective microcomputer. The MPU is the center of the microcomputer system and is shown in a minimum system interfacing with a ROM combination chip. It is not intended that this system be limited to this function but that it be expandable with other parts in the M6800 Microcomputer Family.

GENERAL DESCRIPTION

The MC6846 combination chip may be partitioned into three functional operating sections read-only memory, timer-counter functions, and a parallel I/O port

READ-ONLY MEMORY (ROM)

The mask-programmable ROM section is similar to other ROM products of the M6800 family. The ROM is organized in a 2048 by 8-bit array to provide read-only storage for a minimum microcomputer system. Two mask-programmable chip selects are available for user definition.

Address inputs A0-A10 allow any of the 2048 bytes of ROM to be uniquely addressed. Bidirectional data lines [D0-D7) allow the transfer of data between the MPU and the MC6846

TIMER-COUNTER FUNCTIONS

Under software control this 16-bit binary counter may be programmed to count events, measure frequencies, time intervals, or similar tasks. Internal registers associated with the I/O functions may be selected with AO, A1, and A2. It may also be used for square wave generation, single pulses of controlled duration, and gated signals. Interrupts may be generated from a number of conditions selectable by software programming

The timer/counter control register allows control of the interrupt enable, output enable, selection of an internal or external clock source, a divide-by-8 prescaler, and operating mode. Input pin \overline{CTC} (counter-timer clock) will accept an asynchronous clock pulse to decrement the internal register for the counter-timer. If the divide-by-8 prescaler is used, the maximum clock rate can be four times the master clock frequency. Gate input. (\overline{CTG}) accepts an asynchronous TTL-compatible signal which may be used as a trigger or gating function to the counter-timer. A counter-timer output (CTO) is also available and is under software control being dependent on the timer control register, the gate input, and the clock source

PARALLEL I/O PORT

The parallel bidirectional I/O port has functional operational characteristics similar to the B port on the MC6821 PIA. This includes eight bidirectional data lines and two handshake control signals. The control and operation of these lines are completely software programmable.

The interrupt input (CP1) will set the interrupt flag CSR1 of the composite status register. The peripheral control (CP2) may be programmed to act as an interrupt input (set CSR2) or as a peripheral control output.

SIGNAL DESCRIPTION

BUS INTERFACE

The MC6846 interfaces to the M6800 Bus via an 8-bit bidirectional data bus, two Chip Select lines, a Read/Write line, and eleven address lines. These signals, in conjunction with the M6800 VMA output, permit the MPU to control the MC6846.

BIDIRECTIONAL DATA BUS (D0-D7)

The bidirectional data lines (D0-D7) allow the transfer of data between the MPU and the MC6846. The data bus output drivers are three-state devices which remain in the high-impedance (Off) state except when the MPU performs an MC6846 register or ROM read (R/ $\overline{\rm W}=1$ and I/O Registers or ROM selected).

CHIP SELECT (CS0, CS1)

The CS0 and CS1 inputs are used to select the ROM or I/O timer of the MC6846. They are mask programmed to be active high or active low as chosen by the user.

ADDRESS INPUTS (A0-A10)

The Address Inputs allow any of the 2048 bytes of ROM to be uniquely selected when the circuit is operating in the ROM mode. In the I/O-Timer mode, address inputs A0, A1, and A2 select the proper I/O Register, while A3 through A10 (together with CS0 and CS1) can be used as additional qualifiers in the I/O Select circuitry. (See the section on I/O-Timer Select for additional details)

RESET

The active low state of the RESET input is used to initialize all register bits in the I/O section of the device to their proper values. (See the section on Initialization for reset conditions for timer and peripheral registers.)

ENABLE (E)

This signal synchronizes data transfer between the MPU and the MC6846 It also performs an equivalent synchronization function on the external clock, reset, and gate inputs of the MC6846 Timer section

READ/WRITE (R/W)

This signal is generated by the MPU and is used to control the direction of data transfer on the bidirectional data pins. A low level on the R/\overline{W} input enables the MC6846 input buffers and data is transferred to the circuit during the E pulse when the part has been selected. A high level on the R/\overline{W} input enables the output buffers and data is transferred to the MPU during E when the part is selected.

INTERRUPT REQUEST (IRQ)

The active low $\overline{\text{IRQ}}$ output acts to interrupt the MPU through logic included on the MC6846. This output utilizes an open-drain configuration and permits other interrupt request outputs from other circuits to be connected in a wire-OR configuration

PERIPHERAL DATA (P0-P7)

The peripheral data lines can be individually programmed as either inputs or outputs via the Data Direction Register When programmed as outputs, these lines will drive two standard TTL loads (3.2 mA). They are also capable of sourcing up to 1.0 mA at 1.5 V (Logic "1" output)

When programmed as inputs, the output drivers associated with these lines enter a three-state (high impedance) mode. Since there is no internal pullup for these lines, they represent a maximum 10 μ A load to the circuitry driving them — regardless of logic state

A logic zero at the RESET input forces the peripheral data lines to the input configuration by clearing the Data Direction Register. This allows the system designer to preclude the possibility of having a peripheral data output connected to an external driver output during power-up sequence

INTERRUPT INPUT (CP1)

Peripheral input line CP1 is an input-only that sets the Interrupt Flags of the Composite Status register. The active transition for this signal is programmed by the peripheral control register for the parallel port. CP1 may also act as a strobe for the peripheral data register when it is used as an input latch. Details for programming CP1 are in the section on the parallel peripheral port.

PERIPHERAL CONTROL (CP2)

Peripheral Control line CP2 may be programmed to act as an Interrupt input or Peripheral Control output. As an input, this line has high impedance and is compatible with standard TTL voltage levels. As an output, it is also TTL compatible and may be used as a source of 1 mA at 15 V to directly drive the base of a Darlington transistor switch. This line is programmed by the Peripheral Control Register.

COUNTER TIMER OUTPUT (CTO)

The Counter Timer Output is software programmable by selected bits in the timer/counter control register. The mode of operation is dependent on the Timer control register, the gate input, and the clock source. The output is TTL compatible.

EXTERNAL CLOCK INPUT (CTC)

Input pin CTC will accept asynchronous TTL voltage signals to be used as a clock to decrement the Timer. The high and low levels of the external clock must be stable for at least one system clock period plus the sum of the setup and hold times for the inputs. The asynchronous clock rate can vary from dc to the limit imposed by E setup, and hold times.

The external clock input is clocked in by Enable (E) pulses. Three E periods are used to synchronize and process the external clock. The fourth E pulse decrements the internal counter. This does not affect the input frequency, it merely creates a delay between a clock input transition and internal recognition of that transition by the MC6846. All references to CTC inputs in this document relate to internal recognition.

of the input transition. Note that a clock transition which does not meet setup and hold time specifications may require an additional E pulse for recognition.

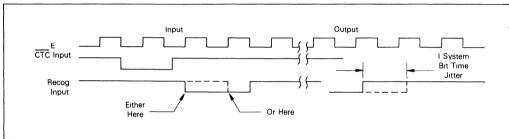
When observing recurring events, a lack of synchronization will result in either "System jitter" or "Input jitter" being observed on the output of the MC6846 when using an asynchronous clock and gate input signal. "System jitter" is the result of the input signals being out of synchronization with E permitting signals with marginal setup and hold time to be recognized by either the bit time nearest the input transition or subsequent bit time. "Input jitter" can be as great as the time between the negative going transitions of the input signal plus the system jitter if the first transition is recognized during one system cycle, and not recognized the next cycle or vice-versa. Refer to Figure 14.

GATE INPUTS (CTG)

The input pin \overline{CTG} accepts an asynchronous TTL-compatible signal which is used as a trigger or a clock gating function to the Timer. The gating input is clocked into the MC6846 by the E signal in the same manner as the previously discussed clock inputs. That is, \overline{CTG} transition is recognized on the fourth Enable pulse (provided setup and hold time requirements are met), and the high or low levels of the \overline{CTG} input must be stable for at least one system clock period plus the sum of setup and hold times. All references to \overline{CTG} transition in this document relate to internal recognition of the input transition.

The $\overline{\text{CTG}}$ input of the timer directly affects the internal 16-bit counter. The operation of $\overline{\text{CTG}}$ is therefore independent of the divide-by-8 prescaler selection.

FIGURE 14 — RECOGNITION OF CTC



FUNCTIONAL SELECT CIRCUITRY

I/O-TIMER SELECT CIRCUITRY

CS0 and CS1 are user programmable. Any of the four binary combinations of CS0 and CS1 can be used to select the ROM. Likewise, any other combination can be used to select the I/O-Timer. In addition, several address lines are used as qualifiers for the I/O-Timer. Specifically, A3 = A4 = A5 = logical "0". A6 can be programmed to a "1", "0", or don't care A7 = A8 = A9 = A10 = don't care or only one line may be programmed to a logical "1". Figure 15 outlines in diagrammatic form the available chip select options

INTERNAL ADDRESS

Seven I/O Register locations within the MC6846 are accessible to the MPU data bus. Selection of these registers is

| REGISTER SELECTED | A2 | Α1 | Α0 |
|-----------------------------|-----|----|----|
| Combination Status Register | 0 | 0 | 0 |
| Peripheral Control Register | 0 | 0 | 1 |
| Data Direction Register | 0 | 1 | 0 |
| Peripheral Data Register | 0 | 1 | 1 |
| Combination Status Register | 1 | 0 | 0 |
| Timer Control Register | 1 | 0 | 1 |
| Timer MSB Register | [1 | 1 | 0 |
| Timer LSB Register | 1 | 1 | 1 |
| ROM Address | × | х | × |

TABLE 1 — INTERNAL REGISTER ADDRESSES

controlled by A0, A1, and A2 (as shown in Table 1) provided the I/O timer is selected. The combination status register is Read-only, all other Registers are Read and Write

INITIALIZATION

When the RESET input has accepted a low signal, all registers are initialized to the reset state. The data direction and peripheral data registers are cleared. The Peripheral Control Register is cleared except for bit 7 (the RESET bit). This forces the parallel port to the input mode with Interrupts disabled. To remove the reset condition from the parallel port, a "0" must be written into the Peripheral Control Register bit 7 (PCR7).

The counter latches are preset to their maximal count, the Timer control register bits are reset to zero except for Bit 0 (TCR0 is set), the counter output is cleared, and the counter clock disabled. This state forces the timer counter to remain in an inactive state. The combination status register is cleared of all interrupt flags. During timer initialization, the reset bit (CCR0) must be cleared.

ROM

The Mask Programmable ROM section is similar in operation to other ROM products of the M6800 Microcessor family. The ROM is organized as 2048 words of 8-bits to provide read-only storage for a minimum microcomputer system. The ROM is active when selected by the unique combination of the chip select inputs.

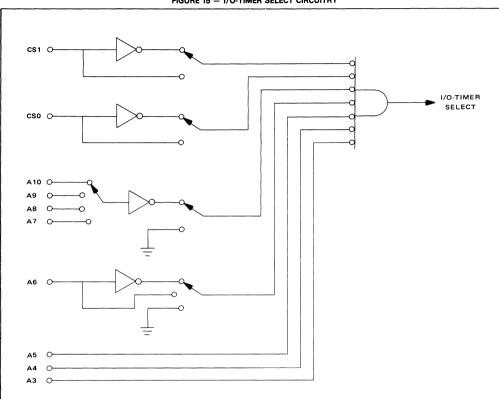


FIGURE 15 - I/O-TIMER SELECT CIRCUITRY

ROM SELECT

The active levels of CS0 and CS1 for ROM and I/O select are a user programmable option. Either CS0 or CS1 may be programmed active high or active low, but different codes

must be used for ROM or I/O select CS0 and CS1 are mask programmed simultaneously with the ROM pattern. The ROM Select Circuitry is shown in Figure 16

CS1 O ROM SELECT CIRCUITRY

CS1 O ROM Select

TIMER OPERATION

The Timer may be programmed to operate in modes which fit a wide variety of applications. The device is fully bus compatible with the M6800 system, and is accessed by Load and Store operations from the MPU.

In a typical application, the timer will be loaded by storing two bytes of data into the counter latch. This data is then transferred into the counter during a Counter Initialization cycle. If enabled, the counter decrements on each subsequent clock cycle (which may be E or an external clock) until one of several predetermined conditions causes it to halt or recycle. Thus, the timer is programmable, cyclic in nature, controllable by external inputs or MPU program, and accessible to the MPU at any time.

COUNTER LATCH INITIALIZATION

The Timer consists of a 16-bit addressable counter and two 8-bit addressable latches. The function of the latches is to store a binary equivalent of the desired count value minus one. Counter initialization results in the transfer of the latch contents of the counter. It should be noted that data transfer to the counters is always accomplished via the latches. Thus, the counter latches may be accurately described as a 16-bit "counter initilization data" storage register.

In some modes of operation, the initialization of the latches will cause simultaneous counter initialization (i.e., immediate transfer of the new latch data into the counters). It is, therefore, necessary to insure that all 16 bits of the latches are updated simultaneously. Since the MC6846 data bus is 8 bits wide, a temporary register (MSB Buffer Register) is provided for the Most Significant Byte of the desired latch data. This is a "wirtte-only" register selected via address lines A0, A1, and A2. Data is transferred directly from the data bus to the MSB Buffer when the chip is selected, R/\overline{W} is low, and the timer MSB register is selected (A0="0", A1=A2="1")

The lower 8 bits of the counter latch can also be referred to as a "write-only" register Data Bus information will be transferred directly to the LSB of a counter latch when the chip is selected, R/\overline{W} is low and the Timer LSB Register is selected (A0=A1=A2="11") Data from the MSB Buffer will automatically be transferred into the Most Significant Byte of the counter latches simultaneously with the transfer of the Data Bus information to the Least Significant Byte of the Counter Latch For brevity, the conditions for this operation will be referred to henceforth as a "Write Timer Latches Command"

The MC6846 has been designed to allow transfer of two bytes of data into the counter latches from any source, provided the MSB is transferred first. In many applications, the source of data will be an M6800 MPU. It should therefore be noted that the 16-bit store operations of the M6800 family microprocessors (STS and STX) transfer data in the order required by the MC6846. A Store Index Register instruction, for example, results in the MSB of the X register being transferred to the selected address, then the LSB of the X register being written into the next higher location. Thus, either the index register or stack pointer may be transferred directly into a selected counter latch with a single instruction.

A logic zero at the RESET input also initializes the counter latches. All latches will assume maximum count (65,535)

values It is important to note that an internal reset (bit zero of the Timer/Control Register Set) has no effect on the counter latches

COUNTER INITIALIZATION

Counter Initialization is defined as the transfer of data from the latches to the counter with attendant clearing of the Individual Interrupt Flag associated with the counter Counter Initialization always occurs when a reset condition (external RESET = "0" or TCRO = "1") is recognized. It can also occur (dependent on The Timer Mode) with a Write Timer Latches command or recognition of a negative transition of the Gate input.

Counter recycling or reinitialization occurs when a clock input is recognized after the counter has reached an all-zero state. In this case, data is transferred from the Latches to the Counter, but the Interrupt Flag is unaffected

TIMER CONTROL REGISTER

The Timer Control Register (see Table 2) in the MC6846 is used to modify timer operation to suit a variety of applications. The Timer Control Register has a unique address space (A0="1", A1="0", A2="1") and therefore may be written into at any time. The least significant bit of the Control Register is used as an internal reset bit. When this bit is a logic zero, all timers are allowed to operate in the modes prescribed by the remaining bits of the timer control register.

Writing "one" into **Timer Control Register B0 (TCR0)** causes the counter to be preset with the contents of the counter latches, all counter clocks are disabled, and the timer output and interrupt flag (Status Register) are reset The Counter Latch and Timer/Control Register are undisturbed by an Internal Reset and may be written into regardless of the state of TCR0

Timer Control Register Bit 1 (TCR1) is used to select the clock source. When TCR1="0", the external clock input $\overline{\text{CTC}}$ is selected, and when TCR1="1", the timer uses E

Timer Control Register Bit 2 (TCR2) enables the divide-by-8 prescaler (TCR2="1") In this mode, the clock frequency is divided by eight before being applied to the counter When TCR2="0" the system clock is applied directly to the counter

TCR3, 4, 5 select the Timer Operating Mode, and are discussed in the next section

Timer Control Register Bit 6 (TCR6) is used to mask or enable the Timer Interrupt Request. When TCR6=''0'', the Interrupt Flag is masked from the timer. When TCR6=''1'', the Interrupt Flag is enabled into Bit 7 of the Composite Status Register (Composite IRQ Bit), which appears on the \overline{IRQ} output pin

Timer Control Register Bit 7 (TCR7) has a special function when the timer is in the Cascaded Single Shot mode. (This function is explained in detail in the section describing the mode) in all other modes, TCR7 merely acts as an output enable bit If TCR7 = "0", the Counter Timer Output (CTO) is forced low Writing a logic one into TCR7 enables CTO For more information on its operation, see the specific mode description

TABLE 2 — FORMAT FOR TIMER/COUNTER CONTROL REGISTER (E)

| CONTROL REGISTER BIT | STATE | BIT DEFINITION | STATE DEFINITION |
|----------------------------|-------------|-----------------------------|-----------------------------------|
| TCR0 | 0 | Internal Reset | Timer Enabled |
| i | 1 | | Timer in Preset State |
| TCR1 | 0 | Clock Source | Timer uses External Clock (CTC) |
| l | 1 | | Timer uses System Clock (E) |
| TCR2 | 0 | | Clock is not Prescaled |
| | 1 | Enabler | Clock is prescaled by - 8 Counter |
| TCR3 TCR4 TCR5 | X X X | Operating Mode Selection | See Table 3 |
| TCR6 | 0 | Timer Interrupt | ÎRQ Masked from Timer |
| | 1 | Enable | ÎRQ Enabled from Timer |
| TCR7 | 0 | Timer Output Enable | Counter Output (CTO) Set LOW |
| | 1 | | Counter Output Enabled |

TIMER OPERATING MODES

The MC6846 has been designed to operate effectively in a wide variety of applications. This is accomplished by using three bits of the control register (TCR3, TCR4, and TCR5) to define different operating modes of the Timer, outlined in Table 3.

CONTINUOUS OPERATING MODE (TCR3=0, TCR5=0)

The timer may be programmed to operate in a continuous counting mode by writing zeros into bits 3 and 5 of the timer control register. Assuming that the timer output is enabled

(TCR7="1"), a square wave will be generated at the Timer Output CTO (see Table 4).

The discussion of the Continuous Mode has assumed the application requires an output signal. It should be noted the Timer operates in the same manner with the output disabled (TCR7="0"). A Read Timer Counter command is valid regardless of the state of TCR7.

TABLE 3 — OPERATING MODES

| TCR3 | TCR4 | TCR5 | Timer Operating Mode | Counter Initialization | Interrupt Flag Set |
|------|------|------|------------------------|---------------------------|--------------------|
| 0 | 0 | 0 | Continuous | CTG↓+W+R | T.O. |
| 0 | 0 | 1 | Cascaded Single Shot | CTG↓+R | T.O. |
| 0 | 1 | 0 | Continuous | CTG↓+R | T.O. |
| 0 | 1 | 1 | Normal Single Shot | CTG↓+R | T.O. |
| 1 | 0 | 0 | Frequency Comparison | CTG↓ • T • (W + T O.) + R | CTG↓ Before T.O. |
| 1 | 0 | 1 | | CTG↓ • T + R | T.O Before CTG↓ |
| 1 | 1 | 0 | Pulse Width Comparison | CTG↓·T+R | CTG↑ Before T.O. |
| 1 | 1 | 1 | | | T.O. Before CTG↑ |

R = Reset Condition

W = Write Timer Latches

T.O. = Counter Time Out

CTG ↓ = Negative Transition of Pin 17

CTG↑ = Positive Transition of Pin 17

T = Interrupt Flag (CSR0) = 0

TABLE 4 - CONTINUOUS OPERATING MODES

| CONTINUOUS MODE (TCR3 = 0, TCR7 = 1, TCR5 = 0) | | | | | | |
|---|------|--------------------------------|--|--|--|--|
| CONTROL INITIALIZATION/OUTPUT WAVEFORMS REGISTER | | | | | | |
| TCR2 | TCR4 | Counter | Timer Output (2X) | | | |
| 0 | 0 | Initialization CTG ↓+ W + R | $(+(N+1)(T) \rightarrow (+($ | | | |
| 0 | 1 | CTG ↓+ R | to T.O. TO. T.O. | | | |

CTG = Negative Transition GATE Input.

W = Write Timer Latches Command.

R = Timer Reset (TCR0 = 1 or External RESET = 0)

N = 16 Bit Number in Counter Latch.

T = Period of Clock Input to Counter.

to = Counter Initialization Cycle.

T.O. = Counter Time Out (All Zero Condition).

NORMAL SINGLE-SHOT TIMER MODE (TCR3=0, TCR4=1, TCR5=1)

This mode is identical to the Continuous Mode with two exceptions. The first of these is obvious from the name—the output returns to a low-level after the initial Time Out and remains low until another Counter Initialization cycle occurs. The output waveform (CTO) is shown in Figure 17

The internal counting mechanism remains cyclical in the Single-Shot Mode Each Time Out of the counter results in

the setting of an Individual Flag and re-initialization of the counter.

The second major difference between the Single-Shot and Continuous modes is that the internal counter enable is not dependent on the $\overline{\text{CTG}}$ input level remaining in the low state for the Single-Shot mode Aside from these differences, the two modes are identical

FIGURE 17 - SINGLE-SHOT MODES

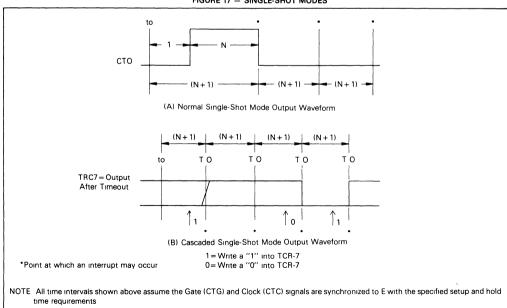


TABLE 5 - TIME INTERVAL MODES

| | TCR3 = 1 | | | | | |
|------|----------|---------------------------|---|--|--|--|
| TCR4 | TCR5 | APPLICATION | CONDITION FOR SETTING INDIVIDUAL INTERRUPT FLAG | | | |
| 0 | 0 | Frequency Comparison | Interrupt Generated if CTG Input Period (1/F) is Less Than Counter Time Out (T.O.) | | | |
| 0 | 1 | Frequency Comparison | Interrupt Generated if CTG Input Period (1/F) Is Greater Than Counter Time Out (T.O.) | | | |
| 1 | 0 | Pulse Width Comparison | Interrupt Generated If CTG Input "Down Time" is Less Than Counter Time Out (T.O.) | | | |
| 1 | 1 | Pulse Width Comparison | Interrupt Generated if CTG Input "Down Time" is Greater Than Counter Time Out (T.O.) | | | |

TIME INTERVAL MODES (TCR3=1)

The Time Interval Modes are provided for applications requiring more flexibility of interrupt generation and Counter Initialization. The Interrupt Flag is set in these modes as a function of both Counter Time Out and transistions of the CTG input. Counter Initialization is also affected by Interrupt Flag status. The output signal is not defined in any of these modes. Other features of the Time Interval Modes are outlined in Table 5.

CASCADED SINGLE-SHOT MODE (TCR3=0, TCR4=0, TCR5=1)

This mode is identical to the single-shot mode with two exceptions. First, the output waveform does not return to a low level and remain low after timeout. Instead, the output levels remains at its initialized level until it is re-programmed and changed by timeout. The output level may be changed at any timeout or may have any number of timeouts between changes.

The second difference is the method used to change the output level Timer Control Register Bit 7 (TCR7) has a special function in this mode. The timer output (CTO) is equal to TCR7 clocked by timeout. At every timeout, the contents of TCR7 is clocked to and held at the CTO output. Thus, output pulses of length greater than one timer cycle can be generated by cascading timer cycles and counting timeouts with a software program. (See Figure 17.)

An interrupt is generated at each timeout. To cascade timer cycles, the MPU would need an interrupt routine to 1) count each timeout and determine when to change TCR7, write into TCR7 the state corresponding to the next desired state of the output waveform (only necessary during the last

timer cycle before the output is to change state), and 3) clear the interrupt flag by reading the combination status register followed by Read Timer MSB. It is also possible, if desired, to change the length of the timer cycle by reinitializing the timer latches. This allows more flexibility for obtaining desired times.

FREQUENCY COMPARISON MODE (TCR3=1, TCR4=0)

The timer within the MC6846 may be programmed to compare the period of a pulse (giving the frequency after calculations) at the CTG input with the time period required for Counter Time Out. A negative transistion of the CTG input enables the counter and starts a Counter Initialization cycle — provided that other conditions, as noted in Table 6, are satisfied. The counter decrements on each clock signal recognized during or after Couter Initialization until an Interrupt is generated, a Write Timer Latches command is issued, or a Timer Reset condition occurs. It can be seen from Table 6 that an interrupt condition will be generated if TCR5="0" and the period of the pulse (single pulse or measured separately repetative pulses) at the CTG input is less than the Counter Time Out period. If TCR5="1", an interrupt is generated if the reverse is true

Assume now with TCR5="1" that a Counter Initialization has occurred and that the CTG input has returned low prior to Counter Time Out. Since there is no Individual Interrupt Flag generated, this automatically starts a new Counter Initialization Cycle. The process will continue with frequency comparison being performed on each CTG input cycle until the mode is changed, or a cycle is determined to be above the predetermined limit.

TABLE 6 - FREQUENCY COMPARISON MODE

| | CRX3 = 1, CRX4 = 0 | | | | | | | |
|-----------------------------|---------------------|--------------------------------------|--|---------------------------|--|--|--|--|
| Control Reg Bit 5 (CRX5) | | Counter Enable Flip-Flop Set (CE) | Counter Enable Flip-Flop Reset (CE) | Interrupt Flag Set (I) | | | | |
| 0 | G↓· Ī· (CE+TO·CE)+R | Ğ↓·₩·R·ĭ | W+R+I | Ğ↓ Before TO | | | | |
| 1 | Ğ↓·Ī+R | Ğ↓W·RĪ | W+R+I | TO Before G | | | | |

I represents the interrupt for the timer.

CRX3 = 1. CRX4 = 1 Control Reg Counter Counter Enable Counter Enable Interrupt Flag Bit 5 (CRX5) Initialization Flip-Flop Set (CE) Flip-Flop Reset (CE) Set (1) Ğ↓·Ĩ+R $\overline{G} \downarrow \overline{W} \cdot \overline{R} \cdot \overline{I}$ G↑ Before TO W+R+I+G G_↓ W·R T Gi-I+R TO Before Gt W+R+I+G

TABLE 7 - PULSE WIDTH COMPARISON MODE

PULSE WIDTH COMPARISON MODE (TCR3=1, TCR4=1)

This mode is similar to the Frequency Comparison Mode except for the limiting factor being a positive, rather than negative, transition of the CTG input With TCR5="0", an Individual Interrupt Flag will be generated if the zero level pulse applied to the CTG input is less than the time period reaured for Counter Time Out With TCR5="1", the interrupt is generated when the reverse condition is true

As can be seen in Table 7, a positive transition of the CTG input disables the counter With TCR5="0", it is therefore possible to directly obtain the width of any pulse causing an interrupt.

DIFFERENCES BETWEEN THE MC6840 AND THE MC6846 TIMERS

- 1) Control registers 1 and 3 are buried (access through control register 2 only) in the MC6840 timer. In the MC6846, all registers are directly accessable.
- 2) The MC6840 has a dual 8-bit continuous mode for generating non-symmetrical waveforms. The MC6846, instead, has a cascaded one shot mode which can accomplish the same function, but also allows the user to generate waveforms longer than one timeout
- 3) Because of the different modes, there is a difference in the control registers between the MC6840 and the MC6846

COMPOSITE STATUS REGISTER

The Composite Status Register (CSR) is a read-only register which is shared by the Timer and the Peripheral Data Port of the MC6846. Three individual interrupt flags in the register are set directly via the appropriate conditions in the timer or peripheral port. The composite interrupt flag - and the IRQ Output - respond to these individual interrupts only if corresponding enable bits are set in the appropriate Control Registers (See Figure 18) The sequence of assertion is not detected Setting TCR6 while CSR0 is high will cause CSR7 to be set, for example.

The Composite Interrupt Flag (CSR7) is clear only if all enabled Individual Interrupt Flags are clear. The conditions for clearing CSR1 and CSR2 are detailed in a later section The Timer Interrupt Flag (CSR0) is cleared under the following conditions

- 1) Timer Reset Internal Reset Bit (TCR0) = "1" or External RESET = "0"
 - 2) Any Counter Initialization condition
- 3) A Write Timer Latches command if Time Interval modes (TCR3="1") are being used
- 4) A Read Timer Counter command, provided this is preceded by a Read Composite Status Register while CSR0 is set. This latter condition prevents missing an Interrupt Request generated after reading the Status Register and prior to reading the counter
- The remaining bits of the Composite Status Register (CSR3-CSR6) are unused They return a logic zero when read

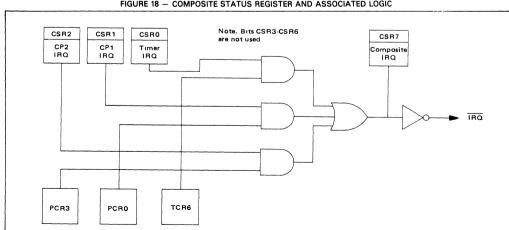


FIGURE 18 - COMPOSITE STATUS REGISTER AND ASSOCIATED LOGIC

I/O OPERATION

PARALLEL PERIPHERAL PORT

The peripheral port of the MC6846 contains eight Peripheral Data lines (P0-P7), two Peripheral Control lines (CP1 and CP2), a Data Direction Register, a Peripheral Data Register, and a Peripheral Control Register. The port also directly affects two bits (CSR1 and CSR2) of the Composite Status Register.

The Peripheral Port is similar to the "B" side of a PIA (MC6820 or MC6821) with the following exceptions:

- 1) All registers are directly accessible in the MC6846. Data Direction and Peripheral Data in the MC6820/6821 are located at the same address, with Bit Two of the Control Register used for register selection.
- 2) Peripheral Control Register Bit Two (PCR2) of the MC6846 is used to select an optional input latch function. This option is not available with MC6820/6821 PIA's.
- 3) Interrupt Flags are located in the MC6846 composite status register rather than Bits 6 and 7 of the Control Register as used in the MC6820/MC6821.
- 4) Interrupt Flags are cleared in the MC6820/6821 by reading data from the Peripheral Data Register. MC6846 Interrupt Flags are cleared by either reading or writing to the Peripheral Data Register provided that this sequence is followed a) Flag Set, b) Read Composite Status Register, c) Read/Write Peripheral Data Register is followed
- 5) Bit 6 of the MC6846 Peripheral Control Register is not used. Bit 7 (PCR7) is an Internal Reset Bit not available on the MC6820/6821.
- 6) The Peripheral Data lines (and CP2) of the MC6846 feature internal current limiting which allows them to directly drive the base of Darlington NPN transistors.

DATA DIRECTION REGISTER

The MPU can write directly to this 8-bit register to configure the Peripheral Data lines as either inputs or outputs. A particular bit within the register (DDRN) is used to control the corresponding Peripheral Data line (PN) With DDRN = "0", PN becomes an input, if DDRN = "1", PN is an output. As an example, writing Hex \$0F into the Data direction Register results in P0 through P3 becoming outputs and P4 through P7 being inputs. Hex \$55 in the Data direction Register results in alternate outputs and inputs at the parallel port.

PERIPHERAL DATA REGISTER

This 8-bit register is used for transferring data between the peripheral data port and the MPU. Any bit corresponding to an output line will be used to drive the output buffer associated with that line. Data in these output bits is normally provided by an MPU Write function. (Input bits — those associated with input lines — are unchanged by a Write Command.) Any input bit will reflect the state of the associated input line if the input latch function is deselected. If the Control Register is programmed to provide input latching, the input bit will retain the state at the time CP1 was activated until the Peripheral Data Register is read by the MPU.

PERIPHERAL CONTROL REGISTER

This 8-bit register is used to control the reset function as well as for selection of optional functions of the two peripheral control lines (CP1 and CP2). The Peripheral Control Register functions are outlined in Table 8.

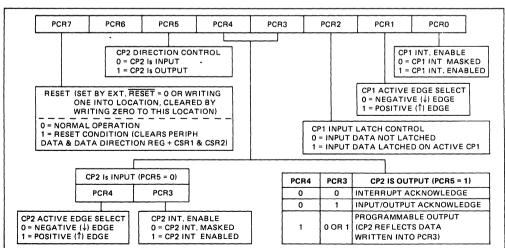


TABLE 8 - PERIPHERAL CONTROL REGISTER FORMAT (EXPANDED)

PERIPHERAL PORT RESET (PCR7)

Bit 7 of the Peripheral Control Register (PCR7) may be used to initialize the peripheral section of the MC6846. When this bit is set high, the peripheral data register, the peripheral data direction register, and the interrupt flags associated with the peripheral port (CSR1 and CSR2) are all cleared. Other bits in the peripheral control register are not affected by PCR7.

PCR7 is set by either a logic zero at the External RESET input or under program control by writing a "one" into the location. In any case, PCR7 may be cleared only by writing a "zero" into the location while RESET is high. The bit must be cleared to activate the port.

CONTROL OF CP1 PERIPHERAL CONTROL LINE

CP1 may be used as an interrupt request to the MC6846, as a strobe to allow latching of input data, or both. In any case, the input can be programmed to be activated by either a positive or negative transition of the signal. These ootions are selected via Control Register Bits PCR0, PCR1, and PCR2.

Control Register Bit 0 (PCR0) is used to enable the interrupt transfer circuitry of the MC6846 Regardless of the state of PCR0, an active transition of CP1 causes the Composite Status Register Bit One (CSR1) to be set If PCR0="1"", this interrupt will be reflected in the Composite Interrupt Flag (CSR7), and thus at the IRQ output. CSR1 is cleared by a Peripheral Port Reset condition or by either reading or writing to the peripheral data register after the Composite Status Register was last read. This precludes inadvertent clearing of interrupt flags generated between the time the Status Register is read and the manipulation of peripheral data

Control Register Bit One (PCR1) is used to select the edge which activates CP1. When PCR1 = "0", CP1 is active on negative transitions (high-to-low) Low-to-high transitions are sensed by CP1 when PCR1 = "1"

In addition to its use as an interrupt input, CP1 can be used as a strope to capture input data in an internal latch. This option is selected by writing a "one" into Peripheral Control Register Bit Two (PCR2). In operation, the data at the pins designated by the Data Direction Register as inputs will be captured by an active transition of CP1. An MPU Read of the Peripheral Data Register will result in the captured data being transferred to the MPU — and it also releases the latch to allow capture of new data. Note that successive active transistions with no Read Peripheral Data Command between does not update the input latch. Also, it should be noted

that use of the input latch function (which can be deselected by writing a zero into PCR2) has no effect on output data. It also does not affect Interrupt function of CP1.

CONTROL OF CP2 PERIPHERAL CONTROL LINE

CP2 may be used as an input by writing a zero into PCR5 In this configuration, CP2 becomes a dual of CP1 in regard to generation of interrupts. An active transition (as selected by PCR4) causes Bit Two of the Composite Status Register to be set. PCR3 is then used to select whether the CP2 transition is to cause CSR7 to be set — and thereby cause $\overline{\text{IRO}}$ to go low. CP2 has no effect on the input latch function of the MC6846.

Writing a one into PCR5 causes CP2 to function as an output PCR4 then determines whether CP2 is to be used in a handshake or programmable output mode With PCR4="11", CP2 will merely reflect the data written into PCR3. Since this can readily be changed under program control, this mode allows CP2 to be a programmable output line in much the same manner as those lines selected as outputs by the Data Direction Register.

The handshaking mode (PCR5="1", PCR4="0") allows CP2 to perform one of two functions as selected by PCR3 With PCR3="1", CP2 will go low on the first positive E transition. This Input/Output Acknowledge signal is released (returns high) on the next positive transition of E

In the Interrupt Acknowledge mode (PCR5="1", PCR4=PCR3="0"), CP2 is set when CSR1 is set by an active transition of CP1 It is released (goes low) on the first positive transition of E after CSR1 has been cleared via an MPU Read or Write to the Peripheral Data Register (Note that the previously described conditions for clearing CSR1 still apply.)

RESET SEQUENCE

A typical reset sequence for the MC6846 will include initialization of both the Peripheral Control and Data Direction Registers of the parallel port. It is necessary to set up the Peripheral Control Register first, since PCR7 = "0" is a condition for writing data into the Data Direction Register (A logic zero at the external $\overline{\text{RESET}}$ input automatically sets PCR7)

SUMMARY

The MC6846 has several optional modes of operation which allow it to be used in a variety of applications. The following tables are provided for reference in selecting these modes.

TABLE 9 - MC6846 INTERNAL REGISTER ADDRESSES

| A2 | A1 | A0 | REGISTER SELECTED |
|----|----|----|-----------------------------|
| 0 | 0 | 0 | Combination Status Register |
| 0 | 0 | 1 | Peripheral Control Register |
| 0 | 1 | 0 | Data Direction Register |
| 0 | 1 | 1 | Peripheral Data Register |
| 1 | 0 | 0 | Combination Status Register |
| 1 | 0 | 1 | Timer Control Register |
| 1 | 1 | 0 | Timer MSB Register |
| 1 | 1 | 1 | Timer LSB Register |
| × | х | × | ROM Address |

TABLE 10 - COMPOSITE STATUS REGISTER

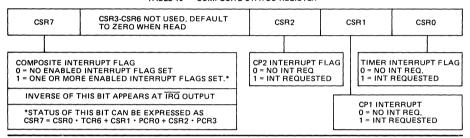
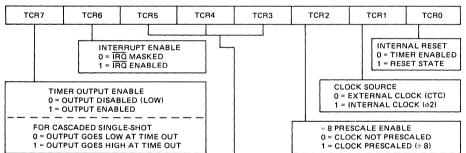


TABLE 11 - TIMER CONTROL REGISTER



| TCR3 | TCR4 | TCR5 | TIMER OPERATING MODE | COUNTER INITIALIZATION | INTERRUPT FLAG SET |
|------|------|------|------------------------|------------------------|--------------------|
| 0 | 0 | 0 | CONTINUOUS | CTG↓+W+R | Т.О. |
| 0 | 0 | 1 | CASCADED SINGLE SHOT | CTG↓+R | T.0 |
| 0 | 1 | 0 | CONTINUOUS | CTG↓+R | T.O. |
| 0 | 1 | 1 | NORMAL SINGLE SHOT | CTG↓+R | T.O. |
| 1 | 0 | 0 | FREQUENCY COMPARISON | CTG↓·I·(W+T.O)+R | CTG↓ BEFORE T.O |
| 1 | 0 | 1 | | CTG↓•T+R | T O. BEFORE CTG↓* |
| 1 | 1 | 0 | PULSE WIDTH COMPARISON | CTG↓•T+R | CTG↑ BEFORE T.O. |
| 1 | 1 | 1 | | | T.O. BEFORE CTG↑ |

R = RESET CONDITION
W = WRITE TIMER LATCHES

T.O. = COUNTER TIME OUT

CTG↓ = NEG TRANSITION OF PIN 17 CTG↑ = POS TRANSITION OF PIN 17 T = INTERRUPT FLAG (CSRO) = 0

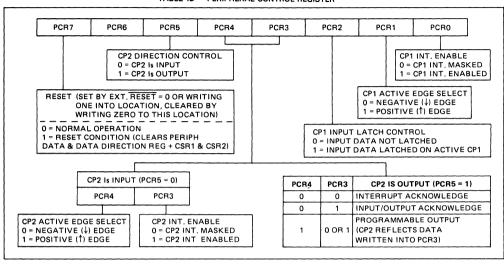


TABLE 12 - PERIPHERAL CONTROL REGISTER

CUSTOM PROGRAMMING*

By the programming of a single photomask for the MC6846, the customer may specify the content of the memory and the method of enabling the outputs

Information on the general options of the MC6846 should be submitted on an Organizational Data form such as that shown in Figure 19.

Information for custom memory content may be sent to Motorola in one of two forms (shown in order of preference):

- 1. EPROMs
- 2 MDOS Diskette

The specification should be formatted and packaged, as indicated in the appropriate paragraph below, and mailed prepaid and insured with a cover letter to

Motorola Inc.

MPU Marketing L2787

3501 Ed Bluestein Blvd

Austin, Texas 78721

A copy of the cover letter should also be mailed separately

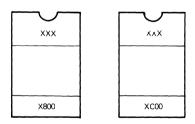
EPROMs

MCM2708 and MCM2716 type EPROMs, programmed with the custom program (positive logic notation for address and data), may be submitted for pattern generation. The MC2708s must be clearly marked to indicate which PROM corresponds to which address space (\$X800-\$XFFF). See Figure A-1 for recommended marking procedure.

- 1 MIKBUG 2 0 MC6846L1,P1
- 2 TVBUG 1 2 MC6846L3,P3

After the EPROM(s) are marked, they should be placed in conductive IC carriers and securely packed. Do not use styrofoam

FIGURE A-1



XX = Customer ID

MDOS DISKETTE

The start/end location should be written on the label, EXORcisor format

^{*}Motorola provides two ROM patterns in the MC6846

FIGURE 19 — FORMAT FOR PROGRAMMING GENERAL OPTIONS

| | GANIZATIONAL DA OMBINATION ROM-I | | ER | | | | | |
|--|-------------------------------------|--------------|-----|-------|--------|--------|------------|-----------------|
| Customer: | | | | Motor | rola U | se Onl | y : | |
| Part No. | | Quote | e: | | | | | |
| Originator | | Part No.: | | | | | | |
| Phone No | | Specif. No.: | | | | | | |
| Enable Options: (ROM ENABLE MUST DIFFE | | | CHE | CK ON | E COL | UMN C | DNLY | |
| 1 0 1 0 | I/O·TIMER SELECT | | | | | | | 1 ≥ 2.0V. |
| cso | A6 | A10 | X | 1 | X | X | | 0 ≤ 0.8V. |
| | | A9 A8 | × | X | 1 X | X 1 | X | X = NOT USED |
| ROM SECTION I/O-TIMER SECTION | | A7 | × | × | × | × | 1 | NOT USED |
| | | | | | | | | |



MC6847 Non-Interlace MC6847Y Interlace

MC6847/MC6847Y VIDEO DISPLAY GENERATOR (VDG)

The video display generator (VDG) provides a means of interfacing the M6800 microprocessor family for similar products) to a standard color or black and white NTSC television receiver. Applications of the VDG include video games, process control displays, home computers, education, communications, and graphics applications

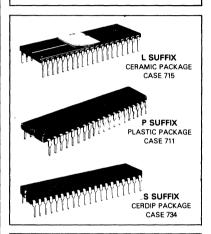
The VDG reads data from memory and produces a video signal which will allow the generation of alphanumeric or graphic displays. The generated video signal may be modulated to either channel 3 or 4 by using the compatible MC1372 (TV chroma and video modulator). This modulated signal is suitable for reception by a standard unmodified television receiver. A typical TV game is shown in Figure 1.

- Compatible with the M6800 Family, the M68000 Family, and Other Microprocessor Families
- Generates Four Different Alphanumeric Display Modes, Two Semigraphic Modes, and Eight Graphic Display Modes
- The Alphanumeric Modes Display 32 Characters Per Line by 16 Lines Using Either the Internal ROM or an External Character Generator
- Alphanumeric and Semigraphic Modes May Be Mixed on a Character-by-Character Basis
- Alphanumeric Modes Support Selectable Inverse on a Characterbv-Character Basis
- Internal ROM May Be Mask Programmed with a Custom Pattern
- Full Graphic Modes Offer 64 × 64, 128 × 64, 128 × 96, 128 × 192, or 256 × 192 Densities
- Full Graphic Modes Use One of Two 4-Color Sets or One of Two 2-Color Sets
- Compatible with the MC1372 and MC1373 Modulators Via Y, R-Y (φA), and B-Y (φB) Interface
- Compatible with the MC6883 (74LS783) Synchronous-Address Multiplexer
- Available in Either an Interlace (NTSC Standard) or Non-interlace Version

MOS

(N-CHANNEL, SILICON-GATE)

VIDEO DISPLAY GENERATOR



PIN ASSIGNMENT 40 DD7 Vss**I**1 ● 39 **1** CSS DD6 38 **1** HS DD0 **[**] 3 37 **1** FS DD1**1**4 36 **□** RP DD2 5 DD3 **1**6 35 1 A/G DD4 7 34**₫**Ā/S DD5 6 8 33 **1** CLK 32 1 INV **СНВ** 19 31 DINT/EXT φB 🗖 10 30 DGM0 φA 🗖 11 29 GM1 MS **□** 12 DA5 13 28 TY 27 GM2 DA6 14 26 DA4 DA7 15 DA8**[**]16 25 DA3 V_{CC} ■17 24 DA2 DA91118 23 DA1 22 DA0 DA10[19 21 DA12 DA11 20

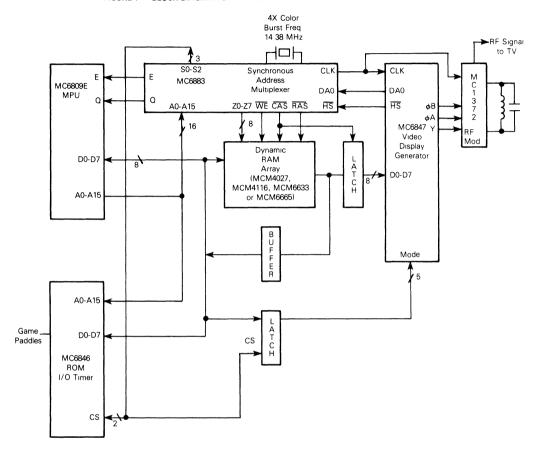


FIGURE 1 - BLOCK DIAGRAM OF A TV GAME USING THE VDG AND THE MC6809E MPU

ELECTRICAL SPECIFICATIONS ABSOLUTE MAXIMUM RATINGS

| Characteristics | Symbol | Value | Unit |
|-----------------------|------------------|--------------|------|
| Supply Voltage | Vcc | -03 to +70 | V |
| Input Voltage Any Pin | V _{in} | -03 to +70 | ٧ |
| Operating Temperature | TA | 0 to +70 | °C |
| Storage Temperature | T _{stg} | -65 to +150 | °C |

THERMAL CHARACTERISTICS

| Characteristics | Symbol | Value | Unit |
|--------------------|--------|-------|-------|
| Thermal Resistance | | | |
| Ceramic | | 50 | °C/W |
| Plastic | θυΑ | 100 | -0/00 |
| Cerdip | | 60 | |

This device contains circuitry to protect the inputs against damage due to high static voltages or electric fields, however, it is advised that normal precautions be taken to avoid application of any voltage higher than maximum rated voltages to this high impedance circuit. Reliability of operation is enhanced if unused inputs are tied to an appropriate logic voltage (e.g., either VSS or VCC).

DC (STATIC) CHARACTERISTICS ($V_{CC} = 5.0 \text{ V} \pm 5\%$, $V_{SS} = 0.0 \text{ V}$, $T_A = 0^{\circ}\text{C}$ to 70°C unless otherwise noted)

| Characteristic | | Symbol | Min | Тур | Max | Unit |
|---|---|--|---|---|--|------|
| Input High Voltage CLK Other Inputs | | V _{IH} | V _{SS} +24 V _{SS} +20 | - | Vcc Vcc | ٧ |
| Input Low Voltage CLK Other Inputs | | VIL | V _{SS} -03 V _{SS} -03 | - | V _{SS} +04 V _{SS} +08 | ٧ |
| Input Leakage Current, Force 5 25 V on Pin Under Test, $V_{CC} = 5.5 \text{ V CLK}$, GM0-GM2, INV, $\overline{\text{INT}}/\text{EXT}$, $\overline{\text{MS}}$, V_{SS} , DD0-DD7, \overline{A}/S , \overline{A}/G | | l _{in} | _ | - | 2 5 | μΑ |
| Three-State (Off State) Input Current DA0-DA12 Force 2 4 V and 0 4 V on Pin Under Test | | loL | _ | - | ± 10 | μΑ |
| Output High Voltage ($C_{Load} = 30 \text{ pF}$, $I_{Load} = -100 \mu A$ | RP, HS, FS | Voн | 2 4 | - | _ | ٧ |
| Output High Voltage (C _{Load} = 55 pF, I _{Load} = -100 μA) | DA0-DA12 | Voн | 2 4 | _ | _ | V |
| Output Low Voltage (C _{Load} = 30 pF, I _{Load} = 1 6 mA) | RP, HS, FS | VOL | _ | _ | Vss+04 | V |
| Output Low Voltage (C _{Load} = 55 pF, I _{Load} = 1 6 mA) | DA0-DA12 | VOL | _ | | Vss+04 | V |
| | All Outputs (Except A, ϕ B, Y, and CHB) | ЮН | - 100 | - | - | μΑ |
| | All Outputs (Except A, ϕ B, Y, and CHB) | loL | 1 6 | _ | _ | mΑ |
| Input Capacitance (V _{ID} = 0, T _A = 25°C, f = 1 0 MHz) | All inputs | C _{in} | | - | 7.5 | pF |
| Internal Power Dissipation (Measured at TA = 0 to 70°C) | | PINT | | _ | 600 | mW |
| Chroma ϕ A Voltage (Figure 3) (CLOad = 20 pF, RLOad = 100 k Ω) (Note 1) | | V _{IH} V _R V _{OL} | 1 8 1 34 0 8 | 2 0 1 5 1 0 | 2 2 1 66 1 2 | ٧ |
| Chroma ϕ B Voltage (Figure 3) (CLOad = 20 pF, RLOad = 100 k Ω) (Note 1) | | VIH VR VOL VBurst | 1 8 1 34 0 80 1 07 | 2 0 1 5 1 0 1 25 | 2 2 1 66 1 2 1 43 | V |
| Luminance Y Voltage (Figure 3) (CLoad = 20 pF, RLoad = 100 kΩ) (Voltage Synchronization) (Voltage Black) (Voltage Black) (Voltage White Low) (Voltage White High) (Note 1) | | VS VBlank VBlack VWL VWM VWH | 0 9 0 63 0 58 0 51 0 40 0 27 | 1 0 0 77 0 72 0 65 0 54 0 42 | 1 1 0 9 0 83 0 75 0 65 0 53 | V |
| Chroma Bias Voltage (C _{Load} = 20 pF, R _{Load} = 100 kΩ) | | VR | 0 27 V _{CC} | 0 3 V _{CC} | 0 33 V _{CC} | V |
| Resistor % of Vss Tracking (Analog Outputs Linearity Error | 1 | RT | | 10 | 3 0 | % |

NOTE 1 The specified minimum and maximum number reflect performance of the VDG of the specified temperature range. Overlapping voltage levels will not occur. Refer to Figure 2

POWER CONSIDERATIONS

The average chip-junction temperature, TJ, in °C can be obtained from:

$$T_{J} = T_{A} + (P_{D} \bullet \theta_{JA})$$
Where

 $T_{\Delta} = Ambient Temperature, °C$

 θ JA = Package Thermal Resistance, Junction-to-Ambient, °C/W

PD≡PINT+PPORT

PINT≡ICC×VCC, Watts - Chip Internal Power

PPORT≡Port Power Dissipation, Watts — User Determined

For most applications PPORT ◀PINT and can be neglected PPORT may become swanificant if the device is configured to drive Darlington bases or sink LED loads

An approximate relationship between PD and TJ (if PPORT is neglected) is

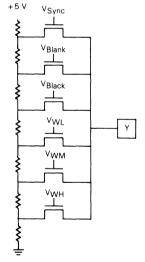
$$P_D = K - (T_J + 273 ^{\circ}C)$$
 (2)

Solving equations 1 and 2 for K gives

 $K = PD \bullet (TA + 273 \circ C) + \theta JA \bullet PD^2$ (3)

Where K is a constant pertaining to the particular part. K can be determined from equation 3 by measuring PD (at equilibrium) for a known T_A . Using this value of K the values of PD and TJ can be obtained by solving equations (1) and (2) iteratively for any value of T_A .

FIGURE 2 - PSEUDO ANALOG LUMINANCE RESISTOR CHAIN

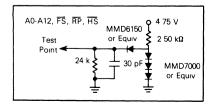


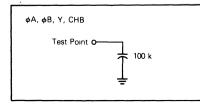
NOTE The chrominance output chain is similar in design to the luminance chain

AC (DYNAMIC) CHARACTERISTICS ($V_{CC} = 5.0 \text{ V } \pm 5\%$, $T_A = 0^{\circ}\text{C}$ to 70°C) (Load Circuit of Figure 3)

| Characteristic | Symbol | Min | Max | Unit | Figure |
|--|----------------------------|------------|------------|--|---------|
| CLK (Frequency (3 579545 Color Burst Frequency) | f | 3 579535 | 3 597555 | MHz | 4 |
| CLK Duty Cycle | CLK _{dc} | 45 | 55 | % | 4 |
| Clock Rise Time | tCLKr | - | 50 | ns | 4 |
| Clock Fall Time | tCLKf | _ | 50 | ns | 4 |
| Clock Pulse Width | PWCLK | 120 | 160 | ns | 4 |
| Horizontal Display Address Delay from Counter DA0-DA3 | tHDAD | _ | 490 | ns | 4, 5, 6 |
| DA4 | tHDA4D | - | 550 | ns | 5, 6 |
| Horizontal Display Address Hold Time | tHDAH | 0 | _ | ns | 4, 5, 6 |
| | tHDA4H | 0 | | 113 | 7, 3, 0 |
| Display Data Setup Time CSS, INV, A/S, INT/EXT, DD0-DD7 | tDDS | 70 | _ | ns | 4, 5, 6 |
| Display Data Hold Time CSS, INV, \$\overline{A}\$/S, \$\overline{INT}\$/EXT, DD0-DD7 | tDDH | 140 | _ | ns | 4, 5, 6 |
| Horizontal Sync (HS) Delay Fall | ^t DHSf | - | 550 | ns | 7 |
| Rise | ^t DHSr | | 740 | 110 | |
| Row Preset (RP) Delay Fall | ^t DRPf | - | 660 | ne | 7 |
| Rise | ^t DRDr | _ | 540 | 113 | |
| Vertical Display Address Delay from Counter DA5-DA12 | tVDAD | | 60 | μS | 7 |
| Vertical Display Address Hold Time | tVDAH | _ | 220 | ns | 7 |
| Field Sync (FS) Delay Fall | tDFSf | - | 520 | ns | 8 |
| Rise | tDFSr | _ | 600 | | |
| Memory Select Low to Display Address High-Impedance | ^t DMST | _ | 80 | ns | 9 |
| Memory Select High to Display Address Valid | tDMSV | | 400 | ns | 9 |
| Chroma Rise and Fall Times | | | | | |
| (♠A Rise Time) | ^t rCφA | - | 100 | | |
| (φA Fall Time) | trøA | _ | 100 100 | | |
| (ya Tali Tille) | tfCøA tføA | _ | 100 | ns | 12 |
| (φB Rise Time) | trC ø B | _ | 100 | 113 | '- |
| ,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,, | trøB | _ | 100 | | |
| (φB Fall Time) | ^t fC φ B | - | 100 | | |
| | ^t fφB | | 100 | ns ns ns ns ns ns ns ns ns ns ns ns ns n | |
| Color Burst Rise Time on ϕB Output | ^t CBr | | 100 | | 12 |
| Color Burst Fall Time on φB Output | tCBf | _ | 100 | ns | 12 |
| Chroma Phase Delay (Measured with Respect to "Y" Output) | | | | | |
| φΑ φΒ | tYA | -50 -50 | 140 140 | ns | 11 |
| Luminance Rise Time | tyB | -50 | 100 | ne | 12 |
| Luminance Fall Time | t _{ry} | | 100 | | 12 |
| Horizontal Sync Rise Time on Y Output | tfy | | 100 | | 12 |
| Horizontal Sync Fall Time on Y Output | tHr tur | | 100 | | 12 |
| Horizontal Blanking Rise Time on Y Output | tHf | | 100 | | 12 |
| Horizontal Blanking Fall Time on Y Output | tHBr | | 100 | | 12 |
| Front Porch Duaration Time (7 × 1/f) | tHBf | 18 | 2.4 | | 12 |
| Back Porch Duration Time (17.5×1/f) | tFP | 45 | 5.4 | <u> </u> | 12 |
| Left Border Duration Time (17 5 × 1/f) | tBP | | | | |
| | tLB | 75 | 83 | | 12 |
| Right Border Duration Time (28 × 1/f) | tRB | 75 | 83 | | 12 |
| Color Burst Duration Time (10 5×1/f) | tCB | 27 | 3.2 | μS | 12 |

FIGURE 3 - TEST LOADS





CLK (Note 1) ^tHDAH DA0-DA3 tDDS-DD0-DD7, CSS

FIGURE 4 — CLOCK AND LONG CYCLE HORIZONTAL ACCESS TIMING

NOTES

- 1 The VDG may power-up using either the rising or falling edge of the clock (dotted line)
- 2 Transitions of DA4-DA12 occur outside the display area DA0-DA3 access the 16 bytes of data displayed during each scan line in the dis-

tDD1

- 3 Long cycle timing applies to CG1, RG1, RG2, and RG3 modes (see Table 3) A/G is high, AS, INT/EXT, and INV input levels do not affect the VDG in long cycle modes
- 4 Usable RAM access time for the long cycle may be calculated using the following equation $\label{eq:transformation} \begin{array}{l} t_{RACL} = 8 \cdot 1 / f_{max} - t_{HDAD_{max}} - t_{DDS_{max}} - t_{CLK} \\ \text{If address and data buffers are used, the access time must be adjusted accordingly} \end{array}$
- 5 All timing is measured to and from a low voltage of 0.8 volts and a high voltage of 2.0 volts unless otherwise specified

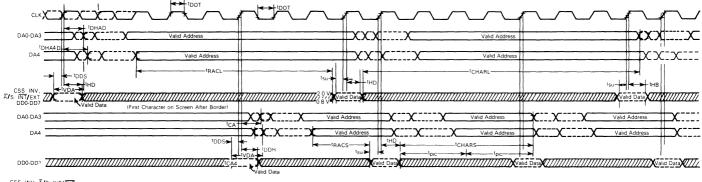
CLK THDAH DA0-DA3 tHDA4H DA4 tDDS-DD0-DD7 CSS, A/G, A/S, INT/EX1 tDDH

FIGURE 5 - SHORT CYCLE HORIZONTAL ACCESS TIMING

NOTES

- 1 The VDG may power-up using either the rising or falling edge of the clock as shown in Figure 4
- 2 Transitions of DA5-DA12 occur outside the display area DA0-DA4 access the 32 bytes of data displayed during each scan line in the dis-
- 3 Short cycle timing applies to the four alphanumeric modes, two semigraphic modes, and to the CG2, CG3, CG6, RG6 modes (see Table 3) For the four graphic modes, \overline{A}/G is high and the \overline{A}/S , \overline{INT}/EXT , and INV input levels do not affect the VDG
- 4 Usable RAM access time for the short cycle may be calculated using the following equation
 - $t_{RACS} = 4 \cdot 1/f_{max} t_{HDA4D_{max}} t_{DDS_{max}} t_{CLKr}$
 - If address and data buffers are used, the access time must be adjusted accordingly
- 5 All timing is measured to and from a low voltage of 0.8 volts and a high voltage of 2.0 volts unless otherwise specified

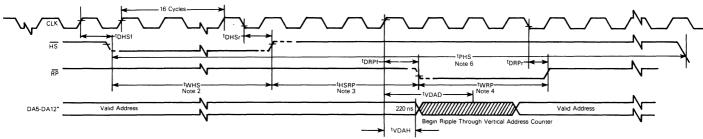
FIGURE 6 — HORIZONTAL ADDRESS AND VALID DATA SETUP AND HOLD TIMING (Timing Relationships Shown From Beginning of Line)



CSS INV A/S INT/EXT DD0-DD7

*Long element/access modes CG1, RG1 RG2 RG3
**Short element/access mode CG2, CG3 CG6 RG6, Alphanumerics Semigraphics

FIGURE 7 — VERTICAL ADDRESS, ROW PRESET AND HORIZONTAL SYNCHRONIZATION TIMING



- NOTES

 All timing is measured to and from a low vol.age of 0.8 volts and a high voltage of 2.0 volts unless otherwise specified

 1. All timing is measured to and from a low vol.age of 0.8 volts and a high voltage of 2.0 volts unless otherwise specified

 2. HS pulse width may be determined by HspR = 3.5 H/f 10HS, + 10RPf

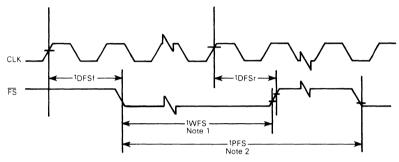
 4. RP pulse width may be determined by HspR = 3.5 H/f 10HS, + 10RPf

 5. DAS-DAIZ will change during the inactive portion of the display

 6. 1PHS = 227.5 + 1/f

- 7 t_{DOT} = ½ f

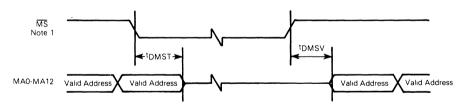
FIGURE 8 - FIELD SYNC (FS) TIMING



NOTES

- 1 twfs = 32 tpHST = 32 (277 5 1/f)
- 2 tpFS = 262*tpHST = 262*(227 5*1/f) for MC6847 tpFS = 262 5*tpHST = 262 5*(227 5*1/f) for MC6847Y

FIGURE 9 - MEMORY SELECT (MS) TIMING



NOTES

1 MS is asserted asynchronously with respect to CLK

TFP [†]HST Note 4 -tAVB ←Left Border Right Border Note 3 tWHS Note 4 -tAV **>|**≺tRB**>**| Note 2 Sync Ā/G Blank Black WL THBNK-Note 5 WM WH End of If $\overline{A}/G = 0$ A/G•CSS Horizontal Ā/G•CSS Ā/G•CSS _tHCD Note 1 Sync V_{IH} Ā/G+Ā/G•CSS φВ VR Ā/G ∙ CSS V_{Burst} VOL (Burst is removed for Ã/G • CSS • GMO) Magenta Orange Red VIH VR VOL $\overline{A}/G + \overline{A}/G \bullet \overline{CSS}$ Blue Yellow Buff

FIGURE 10 - VIDEO AND CHROMINANCE OUTPUT WAVEFORM RELATIONSHIPS

NOTES

Ā/G•ČSS

Green

- 1 t_{HCD} = 3 5•1/f 2 t_{AV} = 128•1/f 3 t_{AVB} = 185 5•1/f 4 Refer to Figure 7
- 5 tHBNK = 42-1/f

FIGURE 11 - CHROMA PHASE DELAY

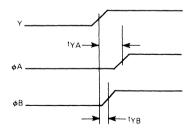
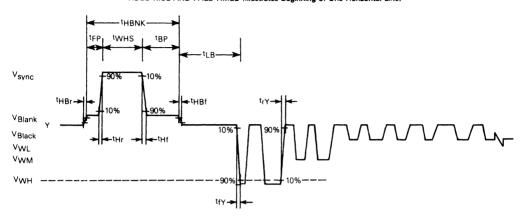
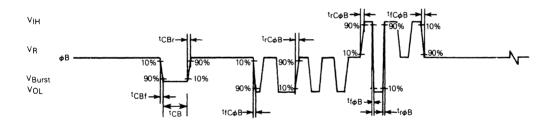


FIGURE 12 — TIMING DIAGRAMS
VIDEO RISE AND FALL TIMES (Illustrates Beginning of One Horizontal Line)





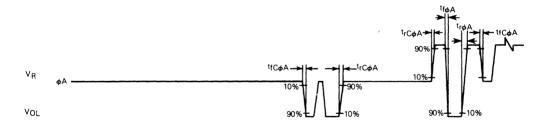


FIGURE 13 - DISPLAY AREA TIMING

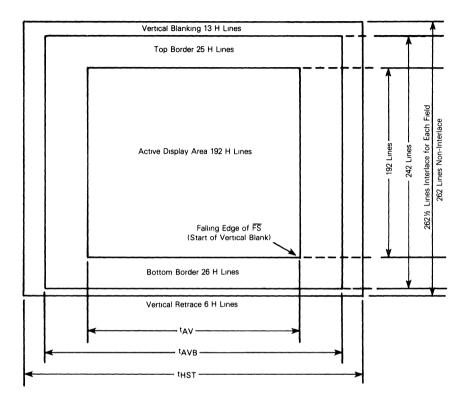
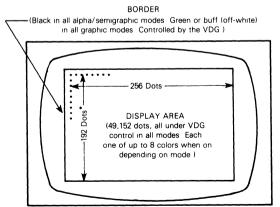


FIGURE 14 - TYPICAL FORMAT OF THE TELEVISION SCREEN



*One on each non-interlaced line, for interlace, the lines of the odd field are copied into the even field thus doubling the number of displayed dots

VIDEO DISPLAY GENERATOR DESCRIPTION

The MC6847/MC6847Y video display generators provide a simple interface for display of digital information on a color monitor or standard color/black and white television receiver.

Television transmissions in North and South America and Japan conform to the National Television System Committee (NTSC) standards This system is based on a field repetition rate of 60 fields per second. There are 525 interlaced lines per frame or one-half this number per field.

The MC6847 scans one field of 262 lines 60 times per second. The MC6847 non-interlace VDG is recommended for use in systems (i.e., TV games and personal computers) where absolute NTSC compatibility is not required. If NTSC compatibility is required, perhaps for caption overlays on broad-case signals, then the MC6847Y interlace VDG is recommended.

NOTE

A system with the MC6847 VDG and the MC1372 video modulator forms a transmitter, transmitting at 61 2 MHz (channel 3) or 67 25 MHz (channel 4) depending on component values chosen This being a Class I TV device, care must be taken to meet FCC requirements Part 15, Subpart H However, if the composite video output from the MC1372 were to drive the television directly, Section 15.7 of the FCC specification must be adhered to.

SIGNAL DESCRIPTION

DISPLAY ADDRESS OUTPUT LINES (DA0-DA12)

Thirteen address lines are used by the VDG to scan the display memory as shown in Figures 4-7. The starting address of the display memory is located at the upper left corner of the display screen. As the television sweeps from the left to right and top to bottom, the VDG increments the RAM display address. The timing for two accesses starting at the beginning of the line is shown in Figure 6. These lines are TTL compatible and may be forced into a high-impedance state whenever MS (pin 12) goes low. A0-A3

change during the active display area. A4 changes during the active display area in the alphanumerics, semigraphics, CG2, CG3, CG6, and RG6 modes. A5-A12 do not toggle within the active display area but instead, ripple through the address during border and blanking time.

DATA INPUTS (DD0-DD7)

Eight TTL compatible data lines are used to input data from RAM to be processed by the VDG. The data is then interpreted and transformed into luminance (Y) and chroma outputs (\$\phi\$A and \$\phi\$B).

POWER INPUTS — V_{CC} requires +5 volts ±5%. V_{SS} requires zero volts and is normally ground. The tolerance and current requirements of the VDG are specified in the Electrical Characteristics.

VIDEO OUTPUTS (ϕ A, ϕ B, Y, CHB) — These four analog outputs are used to transfer luminance and color information to a standard NTSC color television receiver, either via the MC1372 RF modulator or via drivers directly into Y, ϕ A, ϕ B television video inputs (see Figures 10, 11, and 12).

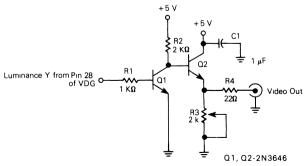
Luminance (Y) — This six level analog output contains composite sync, blanking and four levels of video luminance.

 ϕA — This three level analog output is used in combination with ϕB and Y outputs to specify one of eight colors.

 ϕB — This four level output is used in combination with ϕA and Y outputs to specify one of eight colors. Additionally, one analog level is used to specify the time of the color burst reference signal

Chroma Bias (CHB) — This pin is an analog output and provides a DC reference corresponding to the quiescent value of ϕA and ϕB . CHB is used to guarantee good thermal tracking and minimize the variation between the MC1372 and MC6847. This pin, when pulled low, resets certain registers within the chip. In a user's system, this pin should not normally be used as an input. It is used mainly to enhance test capabilities within the factory

FIGURE 15 - VIDEO TO B&W MONITOR



Contributed by Ted Hanwick, Honeywell, Inc

SYNCHRONIZING INPUTS (MS, CLK)

THREE-STATE CONTROL - (\overline{MS}) is a TTL compatible input which, when low, forces the VDG address lines into a high-impedance state, as shown in Figure 9. This may be done to allow other devices (such as an MPU) to address the display memory (RAM).

CLOCK (CLK) — The VDG clock input (CLK) requires a 3 579545 MHz (standard color burst) TV crystal frequency square wave The duty cycle of this clock must be between 45 and 55% since it controls the width of alternate dots on the television screen. The MC1372 RF modulator may be used to supply the 3 579545 MHz clock and has provisions for a duty cycle adjustment. The VDG will power-up using either the rising or falling edge of the clock. The dotted line on the CLK signal in Figure 4 indicates this characteristic of latching in data on either clock edge.

SYNCHRONIZING OUTPUTS (FS, HS, RP)

Three TTL compatible outputs provide circuits, exterior to the VDG, with timing references to the following internal VDG states:

FIELD SYNC (FS) — The high-to-low transition of the FS output coincides with the end of active display area (see Figure 8). During this time interval, an MPU may have total access to the display RAM without causing undesired flicker on the screen. The low-to-high transition of FS coincides with the trailing edge of the vertical synchronization pulse

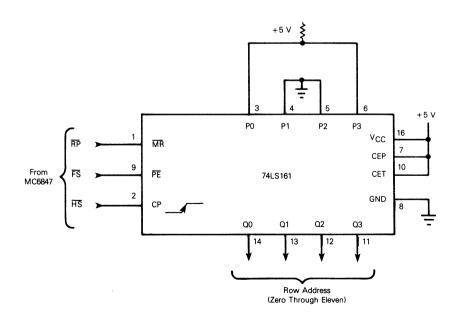
HORIZONTAL SYNC (HS) — The HS pulse coincides with the horizontal synchronization pulse furnished to the television receiver by the VDG (see Figure 7). The high-to-low transition of the HS output coincides with the leading edge of the horizontal synchronization pulse and the low-to-high transition coincides with the trailing edge.

ROW PRESET (RP) — If desired, an external character generator ROM may be used with the VDG. However, an external four bit counter must be added to supply row addresses. The counter is clocked by the $\overline{\rm HS}$ signal and is cleared by the $\overline{\rm RP}$ signal. $\overline{\rm RP}$ pulses occur in all alphanumeric and semigraphics modes; no pulses are output in the full graphic modes. $\overline{\rm RP}$ occurs after the first valid 12 lines. Therefore, use an $\overline{\rm FS}$ clocked preloadable counter such as a 74LS161 as shown in Figures 7. 14, and 23

MODE CONTROL LINES INPUT $(\bar{A}/G, \bar{A}/S, \bar{INT}/EXT, GM0, GM1, GM2, CSS, INV)$

Eight TTL compatible inputs are used to control the operating mode of the VDG \overline{A}/S INT/EXT, CSS, and INV may be changed on a character-by-character basis The CSS pin is used to select between two possible alphanumeric colors when the VDG is in the alphanumeric mode and between two color sets when the VDG is in the Semigraphics 6 or full graphic modes. Table 1 illustrates the various modes that can be obtained using the mode control lines. There are two different types of memory access concerning these modes, they are a short and a long access cycle, which differ by a

FIGURE 16 - EXTERNAL CHARACTER GENERATOR ROW COUNTER FOR MC6847



Ā/G Ā/S INT/EXT INV GM2 GM1 GM0 # of Colors Alpha/Graphic Mode Select 0 0 Internal Alphanumerics 0 0 0 х Internal Alphanumerics Inverted х х 2 n 0 1 ٥ Х Х External Alphanumerics External Alphanumerics Inverted 0 0 1 Х Х Х 1 0 X X ¥ × Semigraphics 4 (SG4) Ω Semigraphics 6 (SG6) 0 1 Х Х Х 8 X X Х 0 0 64 × 64 Color Graphics One (CG1) 4 x Х X Λ 0 128 × 64 Resolution Graphics One (RG1) 2 1 Х Х Х 0 1 128 × 64 Color Graphics Two (CG2) 4 1 Х Х х 0 2 128 × 96 Resolution Graphics Two (RG2) 1 1 1 Χ Х Х 0 Λ 128 × 96 Color Graphics Three (CG3) Δ 1 Х х Х 128 x 192 Resolution Graphics Three (RG3) 1 0 2 1 1 1 Х Х Х 1 O 128 × 192 Color Graphics Six (CG6) 4 Х 256 x 192 Resolution Graphics Six (RG6) 2

TABLE 1 - MODE CONTROL LINES (INPUTS)

shift of one full 3 58 MHz cycle. One of the differences between these access times, in the short access time frame, is a shift of one full 3 58 MHz cycle from the corresponding normal long access time frame, as shown in Figure 6. The modes using short access times read memory twice as often as the long access modes.

OPERATION OF THE VDG

A simplified block diagram of the VDG is shown in Figure 17a and a detailed block diagram is shown in Figure 17b

The externally generated 3 58 MHz color burst clock drives the VDG Referring to Figures 11 and 12, note that the horizontal screen span from blanking to blanking is 193 1 clock periods (\approx 53 95 μs). The display window is offset from the left-hand edge by 283 periods and lasts for 128 periods (35 75 μs). Of the 242 lines on the vertical screen from blanking, 192 lines are used for the display. The display window is offset from the top by 25 lines. Under the constraint of the master clock, the smallest display element possible for the VDG is half period of the 3 58 MHz clock wide by one scan line high. All other display elements are multiples of this basic size

DISPLAY MEMORY ADDRESS DRIVERS

The address drivers normally drive the video refresh address into the display memory so characters may be displayed on the CRT When the memory select pin (MS) is pulled low by an external decoder, the driver outputs go to a high-impedance state so external three-state drivers may switch the MPU produced address onto the display memory address bus, the MPU may directly manipulate data in the display memory

VIDEO TIMING AND CONTROL

This subsystem of the VDG includes the mode decoding, timing generation, and associated row counter logic, and uses the 3 58 MHz color frequency to generate horizontal and vertical timing information (via linear shift register counters), which the video and chroma encoder uses to generate color video information. The horizontal timing for the VDG is summarized in Figure 7. Ten and one-half cycles of the 3 58 MHz subcarrier are transmitted on the back porch.

of every horizontal blanking period. This color burst is suppressed during vertical sync and equalizing intervals Color burst is also suppressed in the most dense two color graphic modes. This leads to some interesting rainbow effects on the display which is frequency and pattern dependent. The vertical timing for the VDG is given in Figure 18 Vertical retrace is initiated by the luminance signal being brought to the blanking level. The vertical blanking period begins with three lines of equalizing pulses followed by three lines of serrated vertical sync pulses followed by three more lines of equalizing pulses. The remaining vertical blanking period contains the normal horizontal sync pulses The equalizing and serration pulses are at half line frequency. Notice the difference in spacing between the last horizontal sync pulse and the first equalizing pulse in even and odd fields, it is the half line difference between fields that produces the interlaced picture in a frame. Vertical timing between fields for the non-interlaced VDG, on the other hand, is identical. The equalizing and serration pulses are, however, at the horizontal frequency

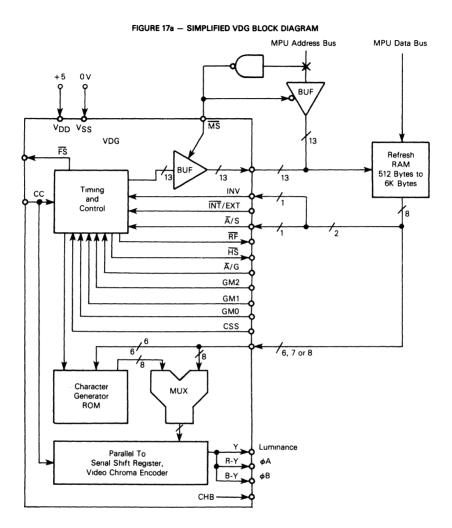
The 3 58 MHz color frequency is also used to clock the video shift register load counter. This counter and the video shift clock inhibit circuitry derive the dot-clock for the output of the video shift registers and the load signals for the video shift registers' input latches. The vertical and horizontal address counters generate the addresses for the external display memory.

INTERNAL CHARACTER GENERATOR ROM

Since many uses of the VDG will involve the display of alphanumeric data, a character-generator ROM is included on the chip. This ROM will generate 64 standard 5×7 dot matrix characters from standard 6-bit ASCII input. A standard character set is included in the MC6847 although the ROM is custom programmable.

INTERNAL/EXTERNAL CHARACTER GENERATOR MULTIPLEXER

The internal /external multiplexer allows the use of either the internal ROM or an external character generator. This multiplexer may be switched on a character-by-character basis to allow mixed internal and external characters on the CRT. The external character may be any desired dot-pattern in the standard 8×12 one-character display matrix, thus allowing the maximum 256×192 screen density.



VIDEO AND COLOR SUBSYSTEM

The 8-bit output of the internal/external multiplexer is serialized in an 8-bit shift register clocked at the dot-clock frequency.

The luminance information from the shift register is summed with the horizontal and vertical sync signals to produce a composite video signal less the chrominance information,

called Y. The luminance signal, Y, and the two chrominance outputs, ϕA (R-Y) and ϕB (B-Y), can be combined (modulated) by an MC1372 into a composite video signal with color. Figures 8, 9, 10, and 16 show the relationship between the luminance and chrominance signals and the resultant color.

FIGURE 17b - DETAILED VDG BLOCK DIAGRAM

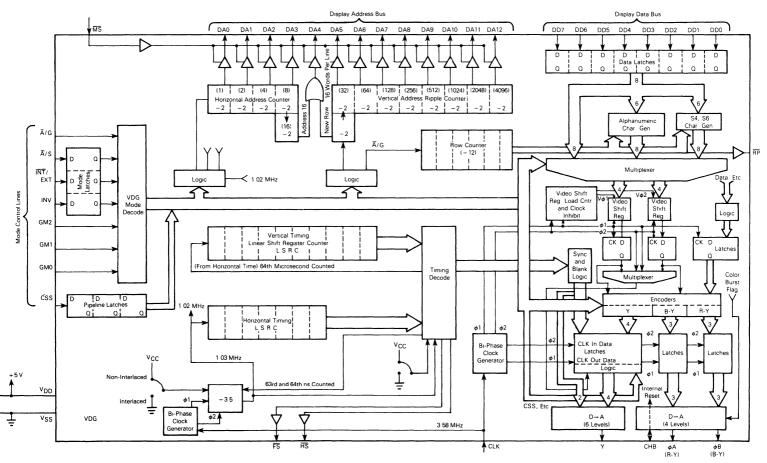
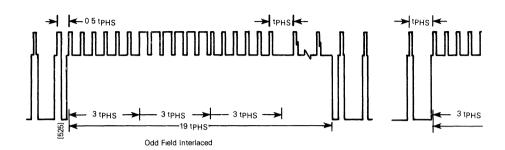
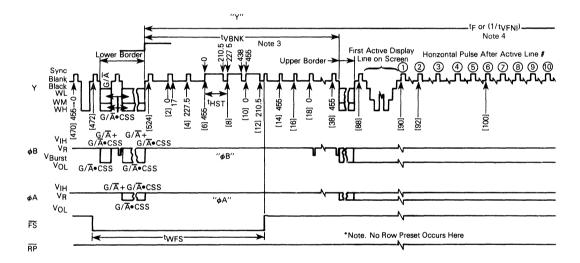


FIGURE 18 — NON-INTERLACE VERTICAL TIMING (For Interlace Vertical Timing Use Inserts)





NOTES

1 [] # of 31 468 kHz clocks (1/31.468 kHz) = 31.7783 μs Non-Parentheses = # of 3 58 MHz Clocks 1/3.58 MHz = 279.366 ns

Time marks 455 and 0 are the same points in time

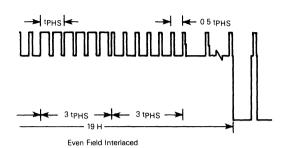
Example Timing Calculations. $t_{HST} = (227.5 \cdot 0) \times 279.366 \text{ ns} = 63.5 \mu s \\ = (455 \cdot 227.5) \times 279.366 \text{ ns} = 63.5 \mu s \\ t_{WHS} = (456 \cdot 438) \times 279.366 \text{ ns} = 4.75 \mu s \\ \text{Lower Border} = (524 \cdot 472) \times 31.7783 \ \mu \text{s-$^{\text{t}}$HBNK} \\ = 1.6525 \text{ ms-}11.6 \text{ ns} = 1.64 \text{ ms}$

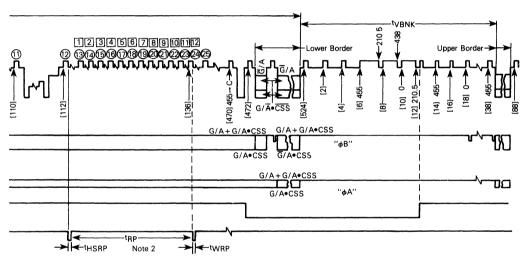
Upper Border = $(88-38) \times 31\ 7783\ \mu s - t_{HBNK} =$ = 1.5889 \(\mu s - 11.6\\mu s = 1\) 58 ms

- 2. tpp = 12 horizontal scan lines
- 3. $t_{VBNK} = 20 \cdot t_{PHS} = 20 \cdot (227.5 \cdot 1/f)$
- 4. t_F= 262*t_{PHS}= 262*(227 5*1/f) for Non-Interlace. t_F= 262.5*T_{PHS}= 262 5*(227.5*1/f) for Interlace

*thenk could actually be considered as part of the border — especially for purposes of writing to the screen. The same holds true for the upper border.

FIGURE 18 — NON-INTERLACE VERTICAL TIMING (For Interlace Vertical Timing Use Inserts) (Continued)





First Row Preset to Occur Comes After the First Active Row of Characters

DISPLAY MODES

There are two major display modes in the VDG Major mode 1 contains four alphanumeric and two limited graphic modes. Major mode 2 contains eight graphic modes. Of these, four are full color graphic and four restricted color graphic modes. The mode selection for the VDG is summarized in Table 2. The mnemonics of these fourteen modes are explained in the following sections.

In major mode 1 the display window is divided into 32 columns by 16 character element rows thus requiring 512 bytes of memory. Each character element is 8 half periods by 12 scan lines in size as shown in Figure 19. The area outside the display window is black.

The VDG has a built-in character generator ROM containing the 64 ASCII characters in a 5×7 format (see Figure 20).

The 5×7 character font is positioned two columns to the right and three rows down within the 8×12 character element. Six bits of the 8-bit data word are typically used for the internal ASCII character generator. The remaining two bits may be used to implement inverse video, color switching, or external character generator ROM selection on a character-by-character basis. For those who wish to display lower case letters, special characters, or even limited-graphics, an external ROM may be used. If such external ROM is used, all of the 8×12 picture elements, or pixels, in the character element can be utilized. Characters may be either green on a dark green background or orange on a dark orange background, depending on the state of the CSS pin. The invertip pin can be used to display dark characters on a bright background.

TABLE 2 — SUMMARY OF MODES Major Mode 1 — Alpha Modes

| Title | Memory | Display Elements | Colors |
|-----------------------------|--------|------------------|--------|
| Alphanumerics (Internal) | 512×8 | 2 5 | 2 |
| | | 7 12 | |
| Alphanumerics (External) | 512×8 | 12 | 2 |

TABLE 2 — SUMMARY OF MODES Major Mode 1 — Alpha Modes (Continued)

| Title | Memory | Display Elements | Colors |
|---------------|---------|------------------|--------|
| Semigraphic 4 | 512 × 8 | Element | 8 |
| Semigraphic 6 | 512×8 | Element | 4 |

Major Mode 2 - Graphics Modes

| Title | Memory | Colors | Comments |
|-------------------------|---------|--------|--|
| 64 × 64 Color Graphic | 1 k×8 | 4 | Matrix 64 × 64 Elements |
| 128 × 64 Graphics* | 1 k×8 | 2 | Matrix 128 Elements Wide by |
| 128 × 64 Color Graphic | 2 k×8 | 4 | 64 Elements High |
| 128×96 Graphics* | 1.5 k×8 | 2 | Matrix 128 Elements Wide by |
| 128×96 Color Graphic | 3 k×8 | 4 | 96 Elements High |
| 128 × 192 Graphics* | 3 k×8 | 2 | Matrix 128 Elements Wide by |
| 128 × 192 Color Graphic | 6 k×8 | 4 | 192 Elements High |
| 256 × 192 Graphics | 6 k×8 | 2 | Matrix 256 Elements Wide by 192 Elements High |

^{*}Graphics mode turns on or off each element. The color may be one of two.

TABLE 3 - DETAILED DESCRIPTION OF VDG MODES

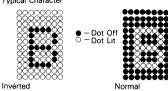
| | | | VE | G Pins | | | | | | | | Color | | | | | | | | |
|----|-----|-----|---------|--------|-----|-----|-----|------------------|---|---|---|--|--|--|--|----------------|--|--|-------|--|
| MS | G/Ā | S/Ā | EXT/INT | GM2 | GM1 | GM0 | CSS | INV | Charact | er Co | | Background | Border | Display Mode | | | | | | |
| 1 | 0 | С | 0 | х | x | x | 0 | 0 1 0 1 | Green Black Orange Black | | | Black Green Black Orange | Black Black | 32 Characters per row 16 Characters in rows | | | | | | |
| 1 | 0 | 0 | 1 | x | х | x | 0 | 0 1 0 1 | Green Black Orange Black | | | Black Green Black Orange | Black Black | 32 Characters per row 16 Characters in rows | | | | | | |
| 1 | 0 | 1 | 0 | х | x | x | × | x | Lx C2 0 X 1 0 1 0 1 0 1 0 1 1 1 1 1 1 | C1 X 0 0 1 1 0 0 | CO X 0 1 0 1 0 | Color Black Green Yellow Blue Red Buff Cyan Magenta | Black | 64 Display elements per row 32 Display elements in rows | | | | | | |
| 1 | 0 | 1 | 1 | х | × | × | 0 | x | 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 | 1 C1 X 0 0 1 1 X 0 0 | 1 CO X 0 1 0 1 X 0 1 | Orange Color Black Green Yel'ow Blue Red Black Buff Cyan Magenta Orange | Black | 64 Display elements per row 48 Display elements in rows | | | | | | |
| 1 | 1 | х | × | 0 | 0 | 0 | 0 | x | | C1 0 0 1 1 0 0 | CO 0 1 0 1 0 1 0 | Color Green Yellow Blue Red Buff Cyan Magenta Orange | Green Buff | 64 Display elements per row 64 Display elements | | | | | | |
| 1 | 1 | × | х | 0 | 0 | 1 | 0 | × | Lx 0 1 0 | | | Color Black Green Black Buff | Green Buff | 128 Display elements per row 64 Display elements in rows | | | | | | |
| 1 | 1 | x | x | 0 | 1 | 0 | 0 | × | | Same color as Color Graphics One | | | Green Buff | 128 Display elements per row 64 Display elements in rows | | | | | | |
| 1 | 1 | × | х | 0 | 1 | 1 | 0 | × | Same co Resolutio Graphics | or: | | | Green Buff | 128 Display elements per row 96 Display elements in rows | | | | | | |
| 1 | 1 | x | х | 1 | 0 | 0 | 0 | х | Same co Color Gr One | | | | Green Buff | 128 Display elements per row 96 Display elements in rows | | | | | | |
| 1 | 1 | × | х | 1 | 0 | 1 | 0 | × | Same color as Resolution Graphics One | | | Green Buff | 128 Display elements per row 192 Display elements in rows | | | | | | | |
| 1 | 1 | x | х | 1 | 1 | 0 | 0 | x | | Same color as Color Graphics One | | Color Graphics | | Color Graphics | | Color Graphics | | | Green | 128 Display elements per row 192 Display Elements in rows |
| 1 | 1 | × | × | 1 | 1 | 1 | 0 | х | Same co Resolution Graphics | n | | | Green Buff | 256 Display elements per row 192 Display elements in rows | | | | | | |

TABLE 3 — DETAILED DESCRIPTION OF VDG MODES (Continued)

| TV Screen | | T |
|---|---|---|
| Detail | VDG Data Bus | Comments |
| 1 2 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 | extra ASCII Code | The ALPHANUMERIC INTERNAL mode uses an internal character generator (which contains the following live dot by seven dot characters@ABCDEFGHIJKLMNOPQRSTUVWXYZ [\ -> 5P "15%" 1" +,, 0123465789 , < = > The six bit ASCII code leaves two bits free and these may be externally connected to the mode pins IG/\overline{A} , S/\overline{A} , EXT/INT, GM2, GM1, GM0, CSS or INV) |
| 8 8 12 | One Row of Custom Characters | The ALPHANUMERIC EXTERNAL mode uses an external character generator as well as a row counter. Thus, custom character fonts or graphic symbol sets with up to 256 different 8 x 12 dot "characters" may be displayed. |
| 6 L ₃ L ₂ 6 L ₁ L ₀ } | C ₂ C ₁ C ₀ L ₃ L ₂ L ₁ L ₀ | The SEMIGRAPHICS FOUR mode uses an internal "course graphics" generator in which a rectangle leight dots by twelve dots! is divided not four equal parts. The luminance of each part is determined by a corresponding bit on the VDG data bus. The color of illuminated parts is determined by three bits. |
| 4 L6 L4 4 L3 L2 4 L1 L0 } One Element | C ₁ C ₀ L ₅ L ₄ L ₃ L ₂ L ₁ L ₀ | The SEMIGRAPHIC SIX mode is similar to the SEMIGRAPHIC FOUR mode with the following differences. The eight dot by twelve dot rectangle is divided into six equal parts. Color is determined by the two remaining bits. |
| E ₃ E ₂ E ₁ E ₀ 3 | C1 C0 C1 C0 C1 C0 C1 C0 | The COLOR GRAPHICS ONE mode uses a maximum of 1024 bytes of display RAM in which one pair of bits specifies one picture element |
| 13 L- L7 L6 L5 L4 L3 L2 L1 L0 3 | L7 L6 L5 L4 L3 L2 L1 L0 | The RESOLUTION GRAPHICS ONE mode uses a maximum of 1024 bytes of display RAM in which one bit specifies one picture element |
| 3 E ₂ E ₁ E ₀ 3 | C ₁ C ₀ C ₁ C ₀ C ₁ C ₀ C ₁ C ₀ | The COLOR GRAPHICS TWO mode uses a maximum of 2048 bytes of display RAM in which one pair of bits specifies one picture element |
| 214- L7 L0 T | L7 L8 L5 L4 L3 L2 L1 L0 | The RESOLUTION GRAPHICS TWO mode uses a maximum of 1536 bytes of display RAM in which one bit specifies one picture element |
| 2 1 2 2 E3 E0 A | C ₁ C ₀ C ₁ C ₀ C ₁ C ₀ C ₁ C ₀ | The COLOR GRAPHICS THREE mode uses a maximum of 3072 bytes of display RAM in which one pair of bytes specifies one picture element |
| → 2 - L7 L0 | L ₇ L ₆ L ₅ L ₄ L ₃ L ₂ L ₁ L ₀ | The RESOLUTION GRAPHICS THREE mode uses a maximum of 3072 bytes of display RAM in which one bit specifies one picture element |
| E ₃ E ₀ | C ₁ C ₀ C ₁ C ₀ C ₁ C ₀ C ₁ C ₀ | The COLOR GRAPHICS SIX mode uses a maximum of 6144 bytes of display RAM in which one pair of bits specifies one picture element |
| →14- L ₇ L ₀ 4 | L7 L6 L5 L4 L3 L2 L1 L0 | The RESOLUTION GRAPHICS SIX mode uses a maximum of 6144 bytes of display RAM in which one bit specifies one picture element |

FIGURE 19 - ALPHANUMERIC MODE (INTERNAL)

512 Characters (32 × 16)
Typical Character



Black Character Orange or Green Background (Selectable) Normal Black Background Orange or Green Character (Selectable)

Character Source:

Internal - 6 Bit ASCII Generator ROM On Chip or User Definable External - Users ROM

The two limited graphic modes are Semigraphics 4 and Semigraphics 6. In Semigraphics 4, the 8×12 dot character block is divided into four pixels (each pixel is four half-clocks by six scan lines). The four low-order bits (DD0-DD3) of each incoming byte of data select one of sixteen possible illumination patterns while the next three bits (DD4-DD6) determine the color of the illuminated elements. The most significant bit is unused. Figure 21 shows the color and pattern selections. In Semigraphics 6 the 8×12 dot character block is divided into six pixels, each four half-clocks by four scan lines. The six low-order bits of each byte of incoming data select one of 64 possible illumination patterns while the CSS input and the high-order data bits (DD6-DD7) determine the color of the illuminated elements

The display window in major mode 2 (full graphics) has a less rigorous format than in major mode 1. The display elements vary from one scan line to three scan lines in height. The length of the display element is either eight or sixteen half-periods wide Each display element is divided into four or eight pixels. The former corresponds to a full color mode while the latter a restricted color mode, like the semigraphics modes, represents illumination data. When it is high the pixel is illuminated with the color chosen by the color set select (CSS) pin. When it is low the pixel is black. In the full color modes, pairs of data bits choose one of four colors in one of two color sets defined by the CSS pin Depending on the state of the CSS pin, the area outside the display window is either green or buff. The display formats and color selection for this major mode are summarized in Figure 19.

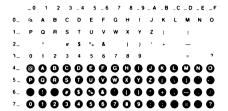
THE 64 × 64 COLOR GRAPHICS ONE (CG1) MODE — The 64 × 64 color graphics mode generates a display matrix of 64 elements wide by 64 elements high. Each element may be one of four colors. A $1k \times 8$ display memory is required The display RAM is accessed 16 times per horizontal line. Each pixel equals four half-clocks by three scan lines

THE 128×64 RESOLUTION GRAPHICS ONE (RG1) MODE — The 128×64 graphics mode generates a matrix 128 elements wide by 64 elements high. Each element may be either ON or OFF. However, the entire display may be one of two colors, selected by using the color set select pin. A 1k×8 display memory is required. The display RAM is accessed 16 times per horizontal line Each pixel equals two half-clocks by three scan lines.

FIGURE 20 - AVAILABLE ALPHANUMERICS

MD4 = INV = D4MD7 = AS = D7

Inverted Character — Illuminated Background,
 Dark Character



THE 128 \times 64 COLOR GRAPHICS TWO (CG2) MODE — The 128 \times 64 color graphics mode generates a display matrix 128 elements wide by 64 elements high. Each element may be one of four colors A $2k \times 8$ display memory is required The display RAM is accessed 32 times per horizontal line Each pixel equals two half-clocks by three scan lines

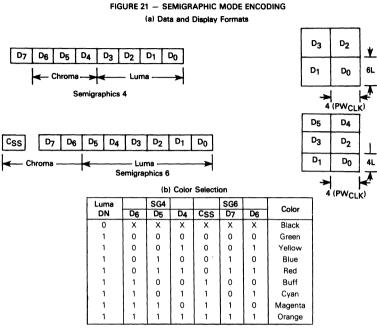
THE 128 \times 96 RESOLUTION GRAPHICS TWO (RG2) MODE — The 128 \times 96 graphics mode generates a display matrix 128 elements wide by 96 elements high Each element may be either ON or OFF However, the entire display may be one of two colors selected by using the color set select pin A 1 5k \times 8 display memory is required. The display RAM is accessed 16 times per horizontal line. Each pixel equals two half-clocks by two scan lines.

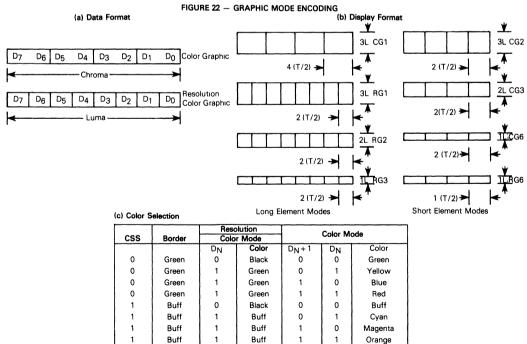
THE 128 \times 96 COLOR GRAPHICS THREE (CG3) MODE — The 128 \times 96 color graphics mode generates a display 128 elements wide by 96 elements high Each element may be one of four colors A $3k \times 8$ display memory is required. The display RAM is accessed 32 times per horizontal line. Each pixel equals two half-clocks by two scan lines.

THE 128×192 RESOLUTION GRAPHICS THREE (RG3) MODE — The 128×192 graphics mode generates a display matrix 128 elements wide by 192 elements high Each element may be either ON or OFF, but the ON element may be one of two colors selected with the color set select pin A 3k×8 display memory is required. The display RAM is accessed 16 times per horizontal line Each pixel equals two half-clocks by one scan line

THE 128 \times 192 COLOR GRAPHICS SIX (CG6) MODE — The 128 \times 192 color graphics mode generates a display 128 elements wide by 192 elements high. Each element may be one of four colors. A 6k \times 8 display memory is required. The display RAM is accessed 32 times per horizontal line. Each pixel equals two half-clocks by one scan line.

THE 256 \times 192 RESOLUTION GRAPHICS SIX (RG6) MODE — The 256 \times 193 graphics mode generates a display 56 elements wide by 192 elements high. Each element may be either ON or OFF, but the ON element may be one of two colors selected with the color set select pin. A 6k \times 8 display memory is required. The display RAM is accessed 32 times per horizontal line. Each pixel equals one half-clock by one scan line.





TYPICAL SYSTEM IMPLEMENTATION

The block diagram in Figure 23 shows how the VDG is related to other functional blocks in a typical system (non-6883). A negative row preset signal (RP) generated by the VDG initializes the row scan counter for the external character generator once every twelve scan lines, while the negative horizontal sync (HS) acts as clock to this counter. The negative field sync (FS) generates an interrupt to the MPU, signifying that the display memory can be updated without interference with the VDG display function. This signal must not be confused with the system vertical sync signal. Field sync is activated by the end of the vertical display window and deactivated by the trailing edge of vertical sync. This gives the MPU a total of thirty-two scan lines or 2.03 ms to update the display memory. The MPU acknowledges the interrupt request from the VDG by bringing the negative memory select input (MS) to the VDG low This puts the address bus output from the VDG into highimpedance state, thus relinquishing bus control to the MPU. The timing relationship of horizontal sync, row preset, and field sync are shown in Figures 7, 8, and 13.

The display memory is an element-by-element map of the display window on the screen. The VDG addresses the display memory storage locations in succession and translates their contents into luminance and chrominance levels. The frequency of address update is dependent on the length of the display element. Recall that display elements in major mode 1 are four periods and major mode 2 are either four or eight periods of the master clock. Data from the display memory is latched on every address transition. Hence, the data for the first display element must be stable four or eight periods before the horizontal display window depending on the display mode selected. This timing requirement is illustrated in Figure 6.

Examination of Figures 21 and 22 reveal that all display elements within major mode 1 are similar while those within major mode 2 are largely dissimilar. Therefore, mode switching between alphanumeric modes and semigraphic modes can be carried out freely. Care must be taken, however, when performing mode switching in major mode 2. The only compatible modes are between CG1 and RG1, and between CG6 and RG6. Minor mode switching within the same major mode in a given element row can be achieved as long as it is between compatible modes. It should be quite apparent that major mode switching on an element-by-element basis is impractical. It can be achieved, however, at the expense of added component count. The element formats in the VDG lend themselves to major mode switching between element.

rows The presence of row preset in major mode 1 serves as a flag for the beginning of a new element row. Detection of this signal can initiate a major mode switch from 1 to 2

Display memory size is a function of the display density Quite often a graphic display contains shapes that are several times larger than that of the display elements in the VDG This is particularly true of certain video games. Much of the display consists of a fixed background. The vertical size of a display element can be doubled or quadrupled by simply ignoring the lowest order or the first two low order vertical addresses, respectively, from the VDG. Reduction of address lines naturally leads to reduction in memory size. Another method of memory reduction is to store objects or object fragments in ROM and store their display addresses in the RAM portion of display memory. Here, the larger the object fragment, the greater the memory saving

ASSOCIATED DEVICES

MC6883 — SYNCHRONOUS ADDRESS MULTIPLEXER (SAM)

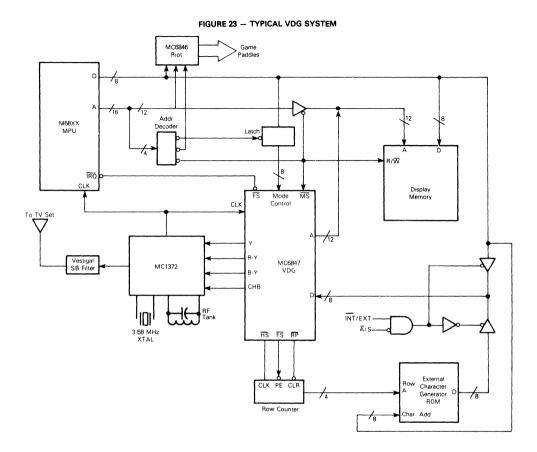
This device, a linear bipolar companion to the MC6800 or MC6809E (external clock inputs), is primarily a VDG transparent-access controller. It allows the microprocessor to load and store to VDG display memory ("screen RAM") without waiting for a blank screen interval. Figure 1 shows a typical system using the SAM and the MC6809E. The inherent interleaved direct memory accesses (IDMA) which occur, continuously keep the VDG updated with the proper data (independently of model), as well as keeping the dynamic memory (used as system memory with the MC6833) refreshed. This is done through a IDMA process as well, during the time the VDG does not need display data (horizontal and vertical synctimes).

In addition to being a transparent memory access and dynamic memory controller, the SAM also functions as an external clock generator for the MC6800/6809E (slight additional circuitry is required for the MC6800).

MC1372/1373 CHROMA/RF MODULATOR

The MC1372 is a chrominance phase-shift modulator with built in RF up-converter. The part may be used without the RF modulator for chroma only, or the RF oscillator may be defeated and composite chrominance and luminance can be obtained.

The MC1373 is an RF modulator only (similar to the second half of the MC1372) and can be used to up-modulate separate luma and chroma signals at the receiver for high quality video reception



APPENDIX A CUSTOM MC6847 ORDERING INFORMATION

The following information is required when ordering a custom MCU. This information may be transmitted to Motorola in the following media.

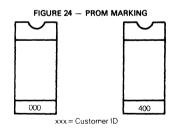
PROM(s) MCM2716s or MCM2708s

MDOS disk file

To initiate a ROM pattern for the MCU it is necessary to first contact your local field service office, local sales person, or your local Motorola representative

PROMs — The MCM2708 or MCM2716 type PROMs, programmed with the customer program (positive logic sense for address and data), may be submitted for pattern generation. The PROMs must be clearly marked to indicate which PROM corresponds to which address space (000-3FF HEX), (400-7FF) or (000-7FF). See Figure 24 for recommended marking procedure.

After the PROM(s) are marked they should be placed in conductive IC carriers and securely packed. Do not use styrofoam



VERIFICATION MEDIA

All original pattern media (PROMs or Floppy Disk) are filed for contractual purposes and are not returned. A computer listing of the ROM code will be generated and returned along with a listing verification form. The listing should be thoroughly checked and the verification form completed, signed, and returned to Motorola. The signed verification form constitutes the contractual agreement for creation of the customer mask. If desired, Motorola will program a blank.

2716 EPROM (supplied by the customer) from the data file used to create the custom mask to aid in the verification process.

ROM VERIFICATION UNITS

Ten MC6847s containing the customer's ROM pattern will be sent for program verification. These units will have been made using the custom mask but are for the purpose of ROM verification only. For expediency they are usually unmarked, packaged in ceramic, and tested only at room temperature and 5 volts. These RVUs are included in the mask charge and are not production parts.

FLEXIBLE DISKS

The disk media submitted must be single-sided, single-density, 8-inch, MDOS compatible floppies. The customer must write the binary file name and company name on the

disk with a felt-tip pen. The floppies are not to be returned by Motorola as they are used for archival storage. The minimum MDOS system files must be on the disk as well as the absolute binary object file (filename LO type of file). An object file made from a memory dump using the ROLLOUT command is also admissable. Consider submitting a source listing as well as the following files filename LX (EXORCISE) loadable format) and filename SA (ASCII Source Code). These files will of course be kept confidential and are used 1) to speed up the process in house if any problems arise, and 2) to speed up our customer to factory interface if a user finds any software errors and needs assistance quickly from the factory representatives.

MDOS is Motorola's Disk Operating System available on development systems such as EXORcisers, or EXORsets, etc

FIGURE A-2

| Customer Name | | |
|---|--------------------------------------|--|
| Address | | |
| | | |
| | State | |
| Contact Ms/Mr | | |
| Customer Part Number | | |
| Pattern Media 2708 PROM 2716 PROM | | |
| MDOS Disk (Note 2) | | |
| Other (NOTE Other me | dia requires prior factory approval) | |
| Signature | | |
| Title | | |
| | | |
| | | |



MC6850 (1.0 MHz) MC68A50 (1.5 MHz) MC68B50

ASYNCHRONOUS COMMUNICATIONS INTERFACE ADAPTER (ACIA)

The MC6850 Asynchronous Communications Interface Adapter provides the data formatting and control to interface serial asynchronous data communications information to bus organized systems such as the MC6800 Microprocessing Unit

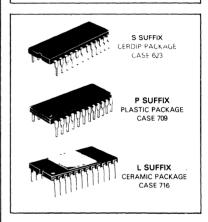
The bus interface of the MC6850 includes select, enable, read/write, interrupt and bus interface logic to allow data transfer over an 8-bit bidirectional data bus. The parallel data of the bus system is serially transmitted and received by the asynchronous data interface, with proper formatting and error checking. The functional configuration of the ACIA is programmed via the data bus during system initialization. A programmable Control Register provides variable word lengths, clock division ratios, transmit control, receive control, and interrupt control. For peripheral or modem operation, three control lines are provided. These lines allow the ACIA to interface directly with the MC6860L 0-600 bps digital modem.

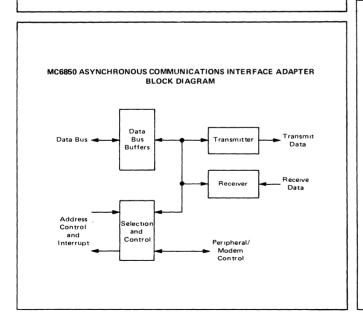
- 8- and 9-Bit Transmission
- Optional Even and Odd Parity
- · Parity, Overrun and Framing Error Checking
- Programmable Control Register
- Optional -1, -16, and -64 Clock Modes
- Up to 1 0 Mbps Transmission
- False Start Bit Deletion
- Peripheral/Modem Control Functions
- Double Buffered
- One- or Two-Stop Bit Operation

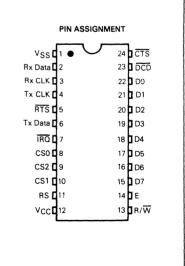
MOS

(N-CHANNEL, SILICON-GATE)

ASYNCHRONOUS
COMMUNICATIONS INTERFACE
ADAPTER







MAXIMUM RATINGS

| Characteristics | Symbol | Value | Unit |
|--|------------------|---|------|
| Supply Voltage | Vcc | -0.3 to +7.0 | ٧ |
| Input Voltage | V _{in} | -0.3 to +7.0 | ٧ |
| Operating Temperature Range MC6850, MC68A50, MC68B50 MC6850C, MC68A50C, MC68B50C | TA | T _L to T _H 0 to 70 -40 to +85 | °C |
| Storage Temperature Range | T _{stg} | -55 to +150 | °C |

This device contains circuitry to protect the inputs against damage due to high static voltages or electric fields, however, it is advised that normal precautions be taken to avoid application of any voltage higher than maximum rated voltages to this high-impedance circuit. Reliability of operation is enhanced if unused inputs are tied to an appropriate logic voltage level (e.g., either VSS or VSC).

THERMAL CHARACTERISTICS

| Characteristic | Symbol | Value | Unit |
|--|--------|-----------------|------|
| Thermal Resistance Plastic Ceramic Cerdip | θJA | 120 60 65 | °C/W |

POWER CONSIDERATIONS

The average chip-junction temperature, TJ, in °C can be obtained from

 $T_J = T_A + (P_D \bullet \theta_{JA})$

(1)

Where

 $T_A = Ambient Temperature, °C$

 θ JA = Package Thermal Resistance, Junction-to-Ambient, °C/W

PD≡PINT+PPORT

 $P_{INT} \equiv I_{CC} \times V_{CC}$, Watts - Chip Internal Power

Pport = Port Power Dissipation, Watts - User Determined

For most applications Pport ◀PINT and can be neglected Pport may become significant if the device is configured to drive Darlington bases or sink LED loads.

An approximate relationship between PD and TJ (if PPORT is neglected) is

 $P_D = K - (T_J + 273 ^{\circ}C)$

(2)

Solving equations 1 and 2 for K gives.

 $K = PD \bullet (TA + 273 \circ C) + \theta JA \bullet PD^2$

(3)

Where K is a constant pertaining to the particular part. K can be determined from equation 3 by measuring P_D (at equilibrium) for a known T_A . Using this value of K the values of P_D and T_J can be obtained by solving equations (1) and (2) iteratively for any value of T_A

DC ELECTRICAL CHARACTERISTICS (V_{CC} = 5 0 Vdc ±5%, V_{SS} = 0, T_A = T_L to T_H unless otherwise noted)

| Characteristic | Symbol | Min | Тур | Max | Unit |
|--|------------------|--|-----------|---------------------|------|
| Input High Voltage | VIH | VSS+20 | - | Vcc | V |
| Input Low Voltage | VIL | V _{SS} -03 | _ | V _{SS} +08 | V |
| $ \begin{array}{lll} \mbox{Input Leakage Current} & \mbox{R/W, CS0, CS1, $\overline{CS2}$, $Enable} \\ \mbox{($V_{\rm IR} = 0$ to 5.25 V)} & \mbox{RS, Rx D, Rx C, \overline{CTS}, \overline{DCD}} \end{array} $ | | - | 10 | 2 5 | μА |
| Three-State (Off State) Input Current D0-D7 (V _{IN} = 0.4 to 2 4 V) | ^I TSI | - | 20 | 10 | μΑ |
| Output High Voltage $ (I_{Load} = -205 \ \mu A, \ Enable \ Pulse \ Width < 25 \ \mu s) $ $ (I_{Load} = -100 \ \mu A, \ Enable \ Pulse \ Width < 25 \ \mu s) $ Tx Data, $\overline{\text{RTS}}$ | Vон | V _{SS} +24 V _{SS} +24 | - | | ٧ |
| Output Low Voltage (I _{Load} = 1 6 mA, Enable Pulse Width < 25 μs) | VOL | | - | V _S S+04 | V |
| Output Leakage Current (Off State) (VOH = 2 4 V) | ^I LOH | | 10 | 10 | μΑ |
| Internal Power Dissipation (Measured at T _A = T _L) | PINT | _ | 300 | 525 | mW |
| | | _ | 10 7 0 | 12 5 7 5 | pF |
| Output Capacitance RTS, Tx Data $(V_{IR} = 0, T_A = 25 ^{\circ}\text{C}, f = 1.0 \text{MHz})$ | C _{out} | _ | _ | 10 5 0 | pF |

SERIAL DATA TIMING CHARACTERISTICS

| Characteristic | | Symbol | MC6850 | | MC68A50 | | MC68B50 | | Unit |
|--|------------------|---------------------------------|--------|-----|----------|-----|---------|------|------|
| | | Symbol | Min | Max | Min | Max | Min | Max | Unit |
| Data Clock Pulse Width, Low | + 16, + 64 Modes | PWCL | 600 | - | 450 | - | 280 | _ | |
| (See Figure 1) | +1 Mode | I WCL | 900 | - | 650 | - | 500 | - | ns |
| Data Clock Pulse Width, High | + 16, + 64 Modes | PWCH | 600 | - T | 450 | - | 280 | - | ns |
| (See Figure 2) | + 1 Mode | FAACH | 900 | | 650 | | 500 | _ | 115 |
| Data Clock Frequency | + 16, + 64 Modes | fc | - | 0.8 | _ | 10 | _ | 15 | MHz |
| | + 1 Mode | ٠ | _ | 500 | - | 750 | _ | 1000 | kHz |
| Data Clock-to-Data Delay for Transmitter (See Figure 3) | | tTDD | - | 600 | - | 540 | - | 460 | ns |
| Receive Data Setup Time (See Figure 4) | + 1 Mode | tRDS | 250 | - | 100 | - | 30 | - | ns |
| Receive Data Hold Time (See Figure 5) | + 1 Mode | tRDH | 250 | - | 100 | _ | 30 | _ | ns |
| Interrupt Request Release Time (See Figure 6) | | ^t IR | - | 12 | - | 09 | - | 07 | μS |
| Request-to-Send Delay Time (See Figure 6) | | ^t RTS | _ | 560 | _ | 480 | - | 400 | ns |
| Input Rise and Fall Times (or 10% of the pulse width if sm | naller) | t _r , t _f | _ | 10 | <u> </u> | 0.5 | - | 0.25 | μS |

FIGURE 1 - CLOCK PULSE WIDTH, LOW-STATE

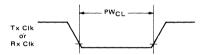


FIGURE 2 - CLOCK PULSE WIDTH, HIGH-STATE

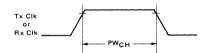


FIGURE 3 — TRANSMIT DATA OUTPUT DELAY

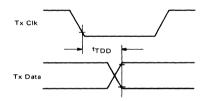


FIGURE 4 — RECEIVE DATA SETUP TIME (+1 Mode)

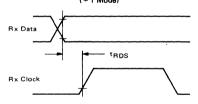


FIGURE 5 — RECEIVE DATA HOLD TIME (+1 Mode)

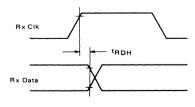
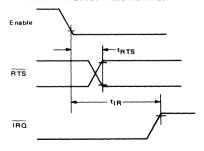


FIGURE 6 — REQUEST-TO-SEND DELAY AND INTERRUPT-REQUEST RELEASE TIMES

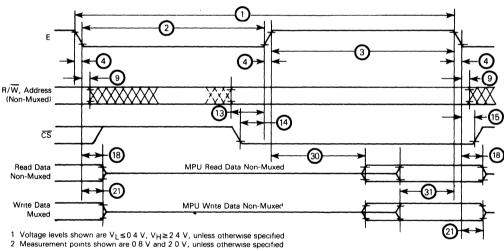


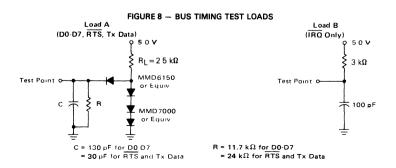
Note Timing measurements are referenced to and from a low voltage of 0.8 volts and a high voltage of 2.0 volts, unless otherwise noted

BUS TIMING CHARACTERISTICS (See Notes 1 and 2 and Figure 7)

| Ident. | Characteristic | Symbol | MC | 6850 | MC6 | 8A50 | MC68B50 | | Unit |
|--------|---------------------------------|---------------------------------|-----|------|------|------|---------|------|------|
| Number | Characteristic | Symbol | Min | Max | Min | Max | Min | Max | Onk |
| 1 - | Cycle Time | tcyc | 1.0 | 10 | 0 67 | 10 | 0.5 | 10 | μS |
| 2 | Pulse Width, E Low | PWEL | 430 | 9500 | 280 | 9500 | 210 | 9500 | ns |
| 3 | Pulse Width, E High | PWEH | 450 | 9500 | 280 | 9500 | 220 | 9500 | ns |
| 4 | Clock Rise and Fall Time | t _r , t _f | - | 25 | - | 25 | _ | 20 | ns |
| 9 | Address Hold Time | ^t AH | 10 | _ | 10 | _ | 10 | _ | ns |
| 13 | Address Setup Time Before E | †AS | 80 | - | 60 | - | 40 | - | ns |
| 14 | Chip Select Setup Time Before E | tCS | 80 | _ | 60 | _ | 40 | - | ns |
| 15 | Chip Select Hold Time | tCH | 10 | - | 10 | - | 10 | - | ns |
| 18 | Read Data Hold Time | †DHR | 20 | 100 | 20 | 100 | 20 | 100 | ns |
| 21 | Write Data Hold Time | tDHW | 10 | - | 10 | _ | 10 | - | ns |
| 30 | Output Data Delay Time | †DDR | - | 290 | - | 180 | _ | 150 | ns |
| 31 | Input Data Setup Time | tDSW | 165 | | 80 | - | 60 | _ | ns |

FIGURE 7 - BUS TIMING CHARACTERISTICS





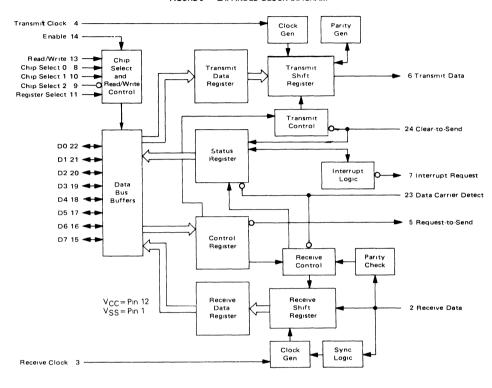


FIGURE 9 - EXPANDED BLOCK DIAGRAM

DEVICE OPERATION

At the bus interface, the ACIA appears as two addressable memory locations. Internally, there are four registers. two read-only and two write-only registers. The read-only registers are Status and Receive Data; the write-only registers are Control and Transmit Data. The serial interface consists of serial input and output lines with independent clocks, and three peripheral/modem control lines.

POWER ON/MASTER RESET

The master reset (CR0, CR1) should be set during system initialization to insure the reset condition and prepare for programming the ACIA functional configuration when the communications channel is required. During the first master reset, the \overline{IRQ} and \overline{RTS} outputs are held at level 1. On all other master resets, the \overline{RTS} output can be programmed high or low with the \overline{IRQ} output held high. Control bits CR5 and CR6 should also be programmed to define the state of \overline{RTS} whenever master reset is utilized. The ACIA also contains internal power-on reset logic to detect the power line turn-on transition and hold the chip in a reset state to prevent erroneous output transitions prior to initialization. This circuitry depends on clean power turn-on transitions. The

power-on reset is released by means of the bus-programmed master reset which must be applied prior to operating the ACIA. After master resetting the ACIA, the programmable Control Register can be set for a number of options such as variable clock divider ratios, variable word length, one or two stop bits, parity (even, odd, or none), etc

TRANSMIT

A typical transmitting sequence consists of reading the ACIA Status Register either as a result of an interrupt or in the ACIA's turn in a polling sequence. A character may be written into the Transmit Data Register if the status read operation has indicated that the Transmit Data Register is empty. This character is transferred to a Shift Register where it is serialized and transmitted from the Transmit Data output preceded by a start bit and followed by one or two stop bits Internal parity (odd or even) can be optionally added to the character and will occur between the last data bit and the first stop bit. After the first character is written in the Data Register, the Status Register can be read again to check for a Transmit Data Register Empty condition and current peripheral status. If the register is empty, another character can be loaded for transmission even though the first character is in the process of being transmitted (because of

double buffering). The second character will be automatically transferred into the Shift Register when the first character transmission is completed. This sequence continues until all the characters have been transmitted.

RECEIVE

Data is received from a peripheral by means of the Receive Data input A divide-by-one clock ratio is provided for an externally synchronized clock (to its data) while the divideby-16 and 64 ratios are provided for internal synchronization Bit synchronization in the divide-by-16 and 64 modes is initiated by the detection of 8 or 32 low samples on the receive line in the divide-by-16 and 64 modes respectively. False start bit deletion capability insures that a full half bit of a start bit has been received before the internal clock is synchronized to the bit time. As a character is being received, parity (odd or even) will be checked and the error indication will be available in the Status Register along with framing error, overrun error, and Receive Data Register full. In a typical receiving sequence, the Status Register is read to determine if a character has been received from a peripheral. If the Receiver Data Register is full, the character is placed on the 8-bit ACIA bus when a Read Data command is received from the MPU. When parity has been selected for a 7-bit word (7 bits plus parity), the receiver strips the parity bit (D7=0) so that data alone is transferred to the MPU. This feature reduces MPU programming. The Status Register can continue to be read to determine when another character is available in the Receive Data Register. The receiver is also double buffered so that a character can be read from the data register as another character is being received in the shift register. The above sequence continues until all characters have been received.

INPUT/OUTPUT FUNCTIONS

ACIA INTERFACE SIGNALS FOR MPU

The ACIA interfaces to the M6800 MPU with an 8-bit bidirectional data bus, three chip select lines, a register select line, an interrupt request line, read/write line, and enable line. These signals permit the MPU to have complete control over the ACIA.

ACIA Bidirectional Data (D0-D7) — The bidirectional data lines (D0-D7) allow for data transfer between the ACIA and the MPU. The data bus output drivers are three-state devices that remain in the high-impedance (off) state except when the MPU performs an ACIA read operation.

ACIA Enable (E) — The Enable signal, E, is a high-impedance TTL-compatible input that enables the bus input/output data buffers and clocks data to and from the ACIA. This signal will normally be a derivative of the MC6800 \$\phi\$2 Clock or MC6809 E clock.

Read/Write (R/W) — The Read/Write line is a high-impedance input that is TTL compatible and is used to control the direction of data flow through the ACIA's input/out-put data bus interface. When Read/Write is high (MPU Read cycle), ACIA output drivers are turned on and a selected register is read When it is low, the ACIA output drivers are

turned off and the MPU writes into a selected register. Therefore, the Read/Write signal is used to select read-only or write-only registers within the ACIA.

Chip Select (CS0, CS1, CS2) — These three high-impedance TTL-compatible input lines are used to address the ACIA. The ACIA is selected when CS0 and CS1 are high and CS2 is low. Transfers of data to and from the ACIA are then performed under the control of the Enable Signal, Read/Write, and Register Select

Register Select (RS) — The Register Select line is a high-impedance input that is TTL compatible. A high level is used to select the Transmit/Receive Data Registers and a low level the Control/Status Registers. The Read/Write signal line is used in conjunction with Register Select to select the read-only or write-only register in each register pair.

Interrupt Request ($\overline{\text{IRQ}}$) — Interrupt Request is a TTL-compatible, open-drain (no internal pullup), active low output that is used to interrupt the MPU. The $\overline{\text{IRQ}}$ output remains low as long as the cause of the interrupt is present and the appropriate interrupt enable within the ACIA is set. The $\overline{\text{IRQ}}$ status bit, when high, indicates the $\overline{\text{IRQ}}$ output is in the active state.

Interrupts result from conditions in both the transmitter and receiver sections of the ACIA. The transmitter section causes an interrupt when the Transmitter Interrupt Enabled condition is selected (CR5•CR6), and the Transmit Data Register Empty (TDRE) status bit is high. The TDRE status bit indicates the current status of the Transmitter Data Register except when inhibited by Clear-to-Send (CTS) being high or the ACIA being maintained in the Reset condition. The interrupt is cleared by writing data into the Transmit Data Register. The interrupt is masked by disabling the Transmitter Interrupt via CR5 or CR6 or by the loss of CTS which inhibits the TDRE status bit. The Receiver section causes an interrupt when the Receiver Interrupt Enable is set and the Receive Data Register Full (RDRF) status bit is high, an Overrun has occurred, or Data Carrier Detect (DCD) has gone high. An interrupt resulting from the RDRF status bit can be cleared by reading data or resetting the ACIA. Interrupts caused by Overrun or loss of DCD are cleared by reading the status register after the error condition has occurred and then reading the Receive Data Register or resetting the ACIA. The receiver interrupt is masked by resetting the Receiver Interrupt Enable.

CLOCK INPUTS

Separate high-impedance TTL-compatible inputs are provided for clocking of transmitted and received data. Clock frequencies of 1, 16, or 64 times the data rate may be selected.

Transmit Clock (Tx CLK) — The Transmit Clock input is used for the clocking of transmitted data. The transmitter initiates data on the negative transition of the clock.

Receive Clock (Rx CLK) — The Receive Clock input is used for synchronization of received data. (In the -1 mode, the clock and data must be synchronized externally.) The receiver samples the data on the positive transition of the clock

SERIAL INPUT/OUTPUT LINES

Receive Data (Rx Data) — The Receive Data line is a high-impedance TTL-compatible input through which data is received in a serial format. Synchronization with a clock for detection of data is accomplished internally when clock rates of 16 or 64 times the bit rate are used.

Transmit Data (Tx Data) — The Transmit Data output line transfers serial data to a modem or other peripheral.

PERIPHERAL/MODEM CONTROL

The ACIA includes several functions that permit limited control of a peripheral or modem. The functions included are Clear-to-Send, Request-to-Send and Data Carrier Detect

Clear-to-Send (CTS) — This high-impedance TTL-compatible input provides automatic control of the transmitting end of a communications link via the modem Clear-to-Send active low output by inhibiting the Transmit Data Register Empty (TDRE) status bit.

Request-to-Send (RTS) — The Request-to-Send output enables the MPU to control a peripheral or modem via the data bus. The RTS output corresponds to the state of the Control Register bits CR5 and CR6 When CR6=0 or both CR5 and CR6=1, the RTS output is low (the active state) This output can also be used for Data Terminal Ready (DTR)

Data Carrier Detect (\overline{DCD}) — This high-impedance TTL-compatible input provides automatic control, such as in the receiving end of a communications link by means of a modem Data Carrier Detect output. The \overline{DCD} input inhibits and initializes the receiver section of the ACIA when high A low-to-high transition of the Data Carrier Detect initiates an interrupt to the MPU to indicate the occurrence of a loss of carrier when the Receive Interrupt Enable bit is set. The Rx CLK must be running for proper \overline{DCD} operation.

ACIA REGISTERS

The expanded block diagram for the ACIA indicates the internal registers on the chip that are used for the status, control, receiving, and transmitting of data. The content of each of the registers is summarized in Table 1

TRANSMIT DATA REGISTER (TDR)

Data is written in the Transmit Data Register during the negative transition of the enable (E) when the ACIA has been addressed with RS high and R/\overline{W} low. Writing data into the register causes the Transmit Data Register Empty bit in the Status Register to go low. Data can then be transmitted if the transmitter is idling and no character is being transmitted, then the transfer will take place within 1-bit time of the trailing edge of the Write command. If a character is being transmitted, the new data character will commence as soon as the previous character is complete. The transfer of data causes the Transmit Data Register Empty (TDRE) bit to indicate empty.

RECEIVE DATA REGISTER (RDR)

Data is automatically transferred to the empty Receive Data Register (RDR) from the receiver deserializer (a shift register) upon receiving a complete character. This event causes the Receive Data Register Full bit (RDRF) in the status buffer to go high (full). Data may then be read through the bus by addressing the ACIA and selecting the Receive Data Register with RS and R/\overline{W} high when the ACIA is enabled. The non-destructive read cycle causes the RDRF bit to be cleared to empty although the data is retained in the RDR. The status is maintained by RDRF as to whether or not the data is current. When the Receive Data Register is full, the automatic transfer of data from the Receiver Shift Register to the Data Register is inhibited and the RDR contents remain valid with its current status stored in the Status Register

TABLE 1 - DEFINITION OF ACIA REGISTER CONTENTS

| | Buffer Address | | | | | | | | |
|-------------------------------|--|---|-----------------------------------|--|--|--|--|--|--|
| Data Bus Line Number | RS ● R/W Transmit Data Register | RS ◆ R/W Receive Data Register | RS ● R/W Control Register | RS ● R/W Status Register | | | | | |
| | (Write Only) | (Read Only) | (Write Only) | (Read Only) | | | | | |
| 0 | Data Bit 0* | Data Bit 0 | Counter Divide Select 1 (CR0) | Receive Data Register Full (RDRF) | | | | | |
| 1 | Data Bit 1 | Data Bit 1 | Counter Divide Select 2 (CR1) | Transmit Data Register Empty (TDRE) | | | | | |
| 2 | Data Bit 2 | Data Bit 2 | Word Select 1 (CR2) | Data Carrier Detect (DCD) | | | | | |
| 3 | Data Bit 3 | Data Bit 3 | Word Select 2 (CR3) | Clear to Send (CTS) | | | | | |
| 4 | Data Bit 4 | Data Bit 4 | Word Select 3 (CR4) | Framing Error (FE) | | | | | |
| 5 | Data Bit 5 | Data Bit 5 | Transmit Control 1 (CR5) | Receiver Overrun (OVRN) | | | | | |
| 6 | Data Bit 6 | Data Bit 6 | Transmit Control 2 (CR6) | Parity Error (PE) | | | | | |
| 7 | Data Bit 7*** | Data Bit 7** | Receive Interrupt Enable (CR7) | Interrupt Request (IRQ) | | | | | |

^{*} Leading bit = LSB = Bit 0

^{**} Data bit will be zero in 7 bit plus parity modes
*** Data bit is "don't care" in 7 bit plus parity modes

CONTROL REGISTER

The ACIA Control Register consists of eight bits of write-only buffer that are selected when RS and R/\overline{W} are low. This register controls the function of the receiver, transmitter, interrupt enables, and the Request-to-Send peripheral/modern control output.

Counter Divide Select Bits (CR0 and CR1) — The Counter Divide Select Bits (CR0 and CR1) determine the divide ratios utilized in both the transmitter and receiver sections of the ACIA. Additionally, these bits are used to provide a master reset for the ACIA which clears the Status Register (except for external conditions on CTS and DCD) and initializes both the receiver and transmitter. Master reset does not affect other Control Register bits. Note that after power-on or a power fail/restart, these bits must be set high to reset the ACIA. After resetting, the clock divide ratio may be selected. These counter select bits provide for the following clock divide ratios:

| CR1 | CR0 | Function |
|-----|-----|--------------|
| 0 | 0 | +1 |
| 0 | 1 | + 16 |
| 1 | 0 | +64 |
| 1 | 1 | Master Reset |

Word Select Bits (CR2, CR3, and CR4) — The Word Select bits are used to select word length, parity, and the number of stop bits. The encoding format is as follows:

| CR4 | CR3 | CR2 | Function | | | | |
|-----|-----|-----|------------------------------------|--|--|--|--|
| 0 | 0 | 0 | 7 Bits + Even Parity + 2 Stop Bits | | | | |
| 0 | 0 | 1 | 7 Bits + Odd Parity + 2 Stop Bits | | | | |
| 0 | 1 | 0 | 7 Bits + Even Parity + 1 Stop Bit | | | | |
| 0 | 1 | 1 | 7 Bits + Odd Parity + 1 Stop Bit | | | | |
| 1 | 0 | 0 | 8 Bits + 2 Stop Bits | | | | |
| 1 | 0 | 1 | 8 Bits + 1 Stop Bit | | | | |
| 1 | 1 | 0 | 8 Bits + Even parity + 1 Stop Bit | | | | |
| 1 | 1 | 1 | 8 Bits + Odd Parity + 1 Stop Bit | | | | |

Word length, Parity Select, and Stop Bit changes are not buffered and therefore become effective immediately.

Transmitter Control Bits (CR5 and CR6) — Two Transmitter Control bits provide for the control of the interrupt from the Transmit Data Register Empty condition, the Request-to-Send (RTS) output, and the transmission of a Break level (space). The following encoding format is used:

| CR6 | CR5 | Function |
|-----|-----|---|
| 0 | 0 | RTS = low, Transmitting Interrupt Disabled. |
| 0 | 1 ! | RTS = low, Transmitting Interrupt Enabled. |
| 1 | 0 ' | RTS = high, Transmitting Interrupt Disabled |
| 1 | 1 | RTS = low, Transmits a Break level on the |
| 1 | 1 ' | Transmit Data Output Transmitting Inter- |
| | 1 | rupt Disabled: |

Receive Interrupt Enable Bit (CR7) — The following interrupts will be enabled by a high level in bit position 7 of the Control Register (CR7): Receive Data Register Full, Overrun, or a low-to-high transition on the Data Carrier Detect (DCD) signal line.

STATUS REGISTER

Information on the status of the ACIA is available to the MPU by reading the ACIA Status Register. This read-only register is selected when RS is low and R/W is high. Information stored in this register indicates the status of the Transmit Data Register, the Receive Data Register and error logic, and the peripheral/modem status inputs of the ACIA.

Receive Data Register Full (RDRF), Bit 0 — Receive Data Register Full indicates that received data has been transferred to the Receive Data Register RDRF is cleared after an MPU read of the Receive Data Register or by a master reset. The cleared or empty state indicates that the contents of the Receive Data Register are not current. Data Carrier Detect being high also causes RDRF to indicate empty

Transmit Data Register Empty (TDRE), Bit 1 — The Transmit Data Register Empty bit being set high indicates that the Transmit Data Register contents have been transferred and that new data may be entered. The low state indicates that the register is full and that transmission of a new character has not begun since the last write data command.

Data Carrier Detect (DCD), Bit 2 — The Data Carrier Detect bit will be high when the DCD input from a modem has gone high to indicate that a carrier is not present. This bit going high causes an Interrupt Request to be generated when the Receive Interrupt Enable is set. It remains high after the DCD input is returned low until cleared by first reading the Status Register and then the Data Register or until a master reset occurs. If the DCD input remains high after read status and read data or master reset has occurred, the interrupt is cleared, the DCD status bit remains high and will follow the DCD input.

Clear-to-Send (CTS), Bit 3 — The Clear-to-Send bit indicates the state of the Clear-to-Send input from a modem. A low CTS indicates that there is a Clear-to-Send from the modem. In the high state, the Transmit Data Register Empty bit is inhibited and the Clear-to-Send status bit will be high Master reset does not affect the Clear-to-Send status bit.

Framing Error (FE), Bit 4 — Framing error indicates that the received character is improperly framed by a start and a stop bit and is detected by the absence of the first stop bit. This error indicates a synchronization error, faulty transmission, or a break condition. The framing error flag is set or reset during the receive data transfer time. Therefore, this error indicator is present throughout the time that the associated character is available.

Receiver Overrun (OVRN), Bit 5 — Overrun is an error flag that indicates that one or more characters in the data stream were lost. That is, a character or a number of characters were received but not read from the Receive Data Register (RDR) prior to subsequent characters being received. The overrun condition begins at the midpoint of the last bit of the second character received in succession without a read of the RDR having occurred. The Overrun does not occur in the Status Register until the valid character prior to Overrun has

MC6850 • MC68A50 • MC68B50

been read. The RDRF bit remains set until the Overrun is reset. Character synchronization is maintained during the Overrun condition. The Overrun indication is reset after the reading of data from the Receive Data Register or by a Master Reset.

Parity Error (PE), Bit 6 — The parity error flag indicates that the number of highs (ones) in the character does not agree with the preselected odd or even parity. Odd parity is defined to be when the total number of ones is odd. The parity error indication will be present as long as the data

character is in the RDR. If no parity is selected, then both the transmitter parity generator output and the receiver parity check results are inhibited.

Interrupt Request (IRQ), Bit 7 — The $\overline{\text{IRQ}}$ bit indicates the state of the $\overline{\text{IRQ}}$ output. Any interrupt condition with its applicable enable will be indicated in this status bit. Anytime the $\overline{\text{IRQ}}$ output is low the $\overline{\text{IRQ}}$ bit will be high to indicate the interrupt or service request status. $\overline{\text{IRQ}}$ is cleared by a read operation to the Receive Data Register or a write operation to the Transmit Data Register.



MC6852 (1.0 MHz) MC68A52 (1.5 MHz) MC68B52 (2.0 MHz)

SYNCHRONOUS SERIAL DATA ADAPTER (SSDA)

The MC6852 Synchronous Serial Data Adapter provides a bidirectional serial interface for synchronous data information interchange. It contains interface logic for simultaneously transmitting and receiving standard synchronous communications characters in bus organized systems such as the M6800 Microprocessor systems.

The bus interface of the MC6852 includes select, enable, read/write, interrupt, and bus interface logic to allow data transfer over an 8-bit bidirectional data bus. The parallel data of the bus system is serially transmitted and received by the synchronized and interface with synchronization, fill character insertion/deletion, and error checking. The functional configuration of the SSDA is programmed via the data bus during system initialization. Programmable control registers provide control for variable world lengths, transmit control, receive control, synchronization control, and interrupt control. Status, timing and control lines provide peripheral or modem control.

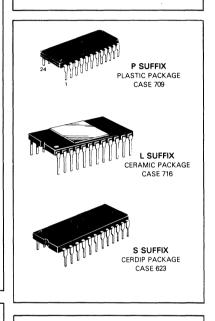
Typical applications include floppy disk controllers, cassette or cartridge tape controllers, data communications terminals, and numerical control systems.

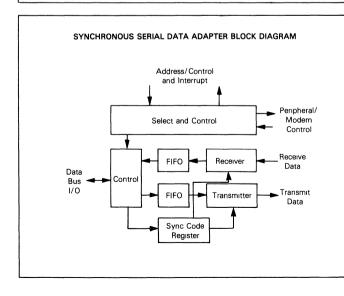
- Programmable Interrupts from Transmitter, Receiver, and Error Detection Logic
- Character Synchronization on One- or Two-Sync Codes
- External Synchronization Available for Parallel-Serial Operation
- Programmable Sync Code Register
- Up to 1.5 MHz Transmission
- Peripheral/Modem Control Functions
- Three Bytes of FIFO Buffering on Both Transmit and Receive
- 7-, 8-, or 9-Bit Transmission
- Optional Even and Odd Parity
- Parity, Overrun, and Underflow Status

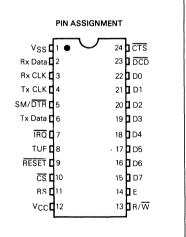
MOS

(N-CHANNEL, SILICON-GATE)

SYNCHRONOUS SERIAL DATA ADAPTER







MAXIMUM RATINGS

| Rating | Symbol | Value | Unit | |
|--|------------------|--|------|--|
| Supply Voltage | Vcc | -0.3 to +7.0 | V | |
| Input Voltage | V _{in} | -0.3 to +7.0 | V | |
| Operating Temperature Range MC6852, MC68A52, MC68B52 MC6852C, MC68A52C | TA | T _L to T _H 0 to +70 -40 to +85 | °C | |
| Storage Temperature Range | T _{stg} | -55 to +150 | °C | |

THERMAL CHARACTERISTICS

| Characteristic | Symbol | Value | Unit | | |
|--------------------|-------------|-------|-------|--|--|
| Thermal Resistance | | | | | |
| Plastic Package | | 120 | °C/W | | |
| Ceramic Package | <i>θ</i> JA | 60 | *C/VV | | |
| Cerdip Package | | 65 | | | |

This device contains circuitry to protect the inputs against damage due to high static voltages or electric fields, however, it is advised that normal precautions be taken to avoid application of any voltage higher than maximum-rated voltages to this high-impedance circuit. Reliability of operation is enhanced if unused inputs are tied to an appropriate logic voltage level (e.g., either VSS or VCC).

(2)

POWER CONSIDERATIONS

The average chip-junction temperature, T.J., in °C can be obtained from:

$$T_{J} = T_{A} + (P_{D} \bullet \theta_{JA})$$
Where

T_A ≡ Ambient Temperature, °C

θ_{JA}≡ Package Thermal Resistance, Junction-to-Ambient, °C/W

PD≡PINT+PPORT

PINT≡ICC×VCC, Watts - Chip Internal Power

PPORT≡Port Power Dissipation, Watts - User Determined

For most applications PpORT ◀PINT and can be neglected PpORT may become significant if the device is configured to drive Darlington bases or sink LED loads

An approximate relationship between PD and TJ (if PPORT is neglected) is

$$P_D = K - (T_J + 273^{\circ}C)$$

Solving equations 1 and 2 for K gives:

$$K = P_{D} \bullet (T_A + 273 \, ^{\circ}C) + \theta_{JA} \bullet P_D^2$$
(3)

Where K is a constant pertaining to the particular part. K can be determined from equation 3 by measuring P_D (at equilibrium) for a known T_A . Using this value of K the values of P_D and T_J can be obtained by solving equations (1) and (2) iteratively for any value of T_A .

DC ELECTRICAL CHARACTERISTICS (V_{CC}=5 0 Vdc ±5%, V_{SS}=0, T_A=T_L to T_H unless otherwise noted)

| Characteristic | Symbol | Min | Тур | Max | Unit |
|--|------------------|--|--------|---------------------|------|
| Input High Voltage | VIH | Vss+20 | _ | _ | V |
| Input Low Voltage | VIL | _ | _ | VSS+08 | V |
| Input Leakage Current Tx CLK, Rx CLK, Rx Data, Enable, (V _{In} = 0 to 5 25 V) RESET, RS, R/W, CS, DCD, CTS | | _ | 10 | 2 5 | μΑ |
| Three-State (Off-State) Input Current (V _{ID} = 0.4 to 2.4 V, V _{CC} = 5.25 V) | IIZ | _ | 20 | 10 | μА |
| Output High Voltage $ (I_{Load} = -205\mu\text{A}, \text{Enable Pulse Width} < 25\mu\text{s}) \\ (I_{Load} = -100\mu\text{A}, \text{Enable Pulse Width} < 25\mu\text{s}) \\ \text{TX Data, } \overline{\text{DTR}}, \text{TUF} $ | | V _{SS} +25 V _{SS} +24 | _ _ | _ _ | ٧ |
| Output Low Voltage (I _{Load} = 1 6 mA, Enable Pulse Width < 25 μs) | VOL | _ | | V _{SS} +04 | V |
| Output Leakage Current (Off-State) (VOH = 2 4 V) | loz | _ | 1.0 | 10 | μΑ |
| Internal Power Dissipation (Measured at TA = TL) | PINT | - | 300 | 525 | mW |
| $\label{eq:capacitance} \begin{array}{llllllllllllllllllllllllllllllllllll$ | 1 | _ | _ | 12 5 7 5 | pF |
| Output Capacitance Tx Data, SM/\overline{DTR} , TUF $(V_{IN} = 0, T_A = 25 ^{\circ}C, f = 1 0 MHz)$ | C _{out} | - | _ | 10 5 0 · | pF |

AC ELECTRICAL CHARACTERISTICS (V $_{CC}$ =5.0 V \pm 5%, V $_{SS}$ =0, T $_{A}$ =T $_{L}$ to T $_{H}$ unless otherwise noted)

| Characteristic | | MC6852 | | MC68A52 | | MC68B52 | | 11-14 |
|--|---------------------------------|--------|------|---------|-------|---------|-------|-------|
| | | Min | Max | Min | Max | Min | Max | Unit |
| Serial Clock Pulse Width, Low (Figure 1) | PWCL | 700 | - | 400 | - | 280 | _ | ns |
| Serial Clock Pulse Width, High (Figure 2) | PWCH | 700 | | 400 | - | 280 | - | ns |
| Serial Clock Frequency (Rx CLK, Tx CLK) | fc | _ | 600 | - | 1000 | - | 1500 | kHz |
| Receive Data Setup Time (Figure 3, 7) | tRDSU | 350 | T - | 200 | _ | 160 | - | ns |
| Receive Data Hold Time (Figure 3) | tRDH | 350 | _ | 200 | | 160 | _ | ns |
| Sync Match Delay Time (Figure 3) | tSM | _ | 10 | - | 0 666 | _ | 0 500 | μS |
| Clock-to-Data Delay for Transmitter (Figure 4) | T _{DD} | _ | 10 | _ | 0 666 | _ | 0 500 | μS |
| Transmitter Underflow (Figures 4, 6) | tTUF | - | 10 | - | 0 666 | - | 0 500 | μS |
| DTR Delay Time (Figure 5) | tDTR | | 10 | | 0 666 | _ | 0 500 | μS |
| Interrupt Request Release Time (Figure 5) | tıR | - | 16 | - | 1 1 | - | 0 850 | μS |
| RESET Pulse Width | tRESET | 10 | _ | 0 666 | - | 0 500 | _ | μS |
| CTS Setup Time (Figure 6) | tCTS | 200 | _ | 150 | _ | 120 | _ | ns |
| DCD Setup Time (Figure 7) | tDCD | 500 | _ | 350 | _ | 250 | _ | ns |
| Input Rise and Fall Times (Except Enable) | t _r , t _f | _ | 1 0* | - | 10* | | 1 0* | μS |

^{*1.0} µs or 10% of the pulse width, whichever is smaller

FIGURE 1 - CLOCK PULSE WIDTH, LOW-STATE

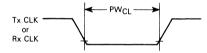


FIGURE 2 - CLOCK PULSE WIDTH, HIGH-STATE

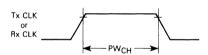
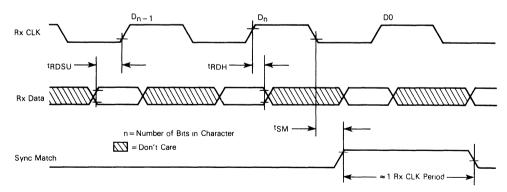
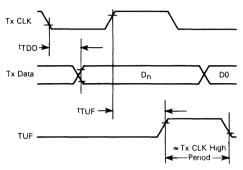


FIGURE 3 - RECEIVE DATA SETUP AND HOLD TIMES AND SYNC MATCH DELAY TIME



Note Timing measurements are referenced to and from a low voltage of 0.8 volts and a high voltage of 2.0 volts, unless otherwise noted

FIGURE 4 — TRANSMIT DATA OUTPUT DELAY AND TRANSMITTER UNDERFLOW DELAY TIME



n = Number of bits in character

FIGURE 5 — DATA TERMINAL READY AND INTERRUPT REQUEST RELEASE TIMES

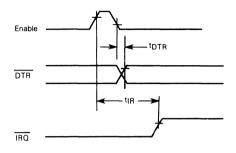


FIGURE 6 - CLEAR-TO-SEND SETUP TIME

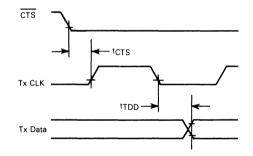
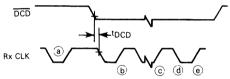


FIGURE 7 - DATA CARRIER DETECT SETUP TIME



Notes

- a Must occur before DCD goes low.
- b First data bit placed in Rx shift register
- c Last data bit of byte placed in Rx shift register
- d Rx data byte transferred from shift register to Rx FIFO
- e Clock edge required for generation of IRO by RDA status Note Refer to Figure 3 for the Rx data setup and hold times

Note Timing measurements are referenced to and from a low voltage of 0.8 volts and a high voltage of 2.0 volts, unless otherwise noted

BUS TIMING TEST LOADS

Load A (D0-D7, DTR, Tx Data, TUF)

5 0 V

R_L= 2 5 kΩ

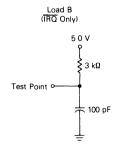
MMD6150 or Equiv

C

R

MMD7000 or Equiv

C = 130 pF for D0-D7= 30 pF for \overline{DTR} , Tx Data, and TUF



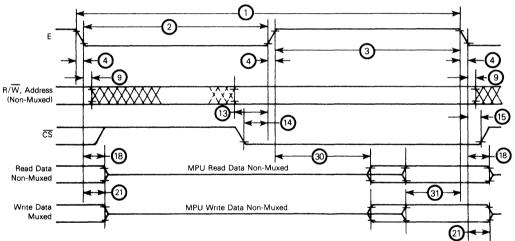
R = 11 7 kΩ for D0-D7 = 24 kΩ for \overline{DTR} , Tx Data, and TUF

BUS TIMING CHARACTERISTICS (See Notes 1 and 2)

| Indent | Characteristic | Symbol | MC6852 | | MC68A52 | | MC68B52 | | Unit |
|--------|---------------------------------|---------------------------------|--------|-----|---------|-----|---------|-----|------|
| Number | | Symbol | Min | Max | Min | Max | Min | Max | Unit |
| 1 | Cycle Time | tcyc | 10 | 10 | 0 67 | 10 | 05 | 10 | μS |
| 2 | Pulse Width, E Low | PWEL | 430 | - | 280 | - | 210 | | ns |
| 3 | Pulse Width, E High | PWEH | 450 | _ | 280 | - | 220 | | ns |
| 4 | Clock Rise and Fall Time | t _r , t _f | - | 25 | - | 25 | - | 20 | ns |
| 9 | Address Hold Time | ^t AH | 10 | - | 10 | - | 10 | - | ns |
| 13 | Address Setup Time Before E | tAS | 80 | - | 60 | _ | 40 | _ | ns |
| 14 | Chip Select Setup Time Before E | tcs | 80 | - | 60 | | 40 | - | ns |
| 15 | Chip Select Hold Time | ^t CH | 10 | - | 10 | _ | 10 | _ | ns |
| 18 | Read Data Hold Time | tDHR | 20 | 50* | 20 | 50* | 30 | 50* | ns |
| 21 | Write Data Hold Time | tDHW | 10 | - | 10 | - | 10 | _ | ns |
| 30 | Output Data Delay Time | ^t DDR | _ | 290 | | 180 | | 150 | ns |
| 31 | Input Data Setup Time | tDSW | 165 | - | 80 | - | 60 | - | ns |

^{*}The data bus output buffers are no longer sourcing or sinking current by tDHRmax (High Impedance)

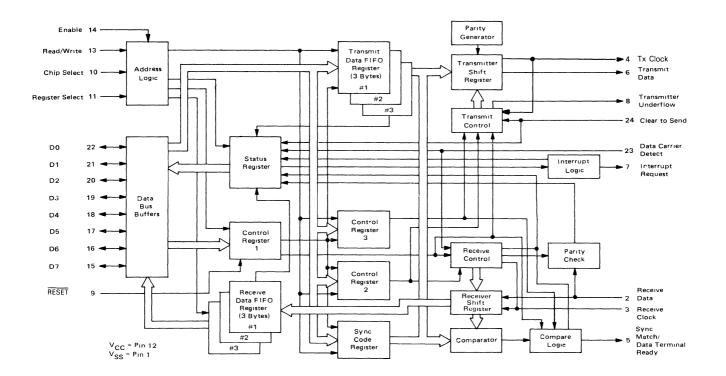
FIGURE 8 - BUS TIMING CHARACTERISTICS (READ/WRITE INFORMATION)



Notes

- 1. Voltage levels shown are $V_L \le 0.4$ V, $V_H \ge 2.4$ V, unless otherwise specified 2. Measurement points shown are 0.8 V and 2.0 V, unless otherwise specified

EXPANDED BLOCK DIAGRAM



DEVICE OPERATION

At the bus interface, the SSDA appears as two addressable memory locations Internally, there are seven registers two read-only and five write-only registers. The read-only registers are Status and Receive Data, the write-only registers are Control 1, Control 2, Control 3, Sync Code and Transmit Data. The serial interface consists of serial input and output lines with independent clocks, and four peripheral/modem control lines.

Data to be transmitted is transferred directly into the 3-byte Transmit Data First-In First-Out (FIFO) Register from the data bus. Availability of the input to the FIFO is indicated by the TDRA bit in the Status Register, once data is entered, it moves through the FIFO to the last empty location. Data at the output of the FIFO is automatically transferred from the FIFO to the Transmitter Shift Register as the shift register becomes available to transmit the next character. If data is not available from the FIFO (underflow condition), the Transmitter Shift Register is automatically loaded with either a sync code or an all "1's" character. The transmit seciton may be programmed to append even, odd, or no parity to the transmitted word. An external control line (Clear-to-Send) is provided to inhibit the transmitter without clearing the FIFO.

Serial data is accumulated in the receiver based on the synchronization mode selected. In the external sync mode, used for parallel-serial operation, the receiver is synchronized by the DCD (Data Carrier Detect) input (Figure 9) and transfers successive bytes of data to the input of the Receiver FIFO. The single-sync-character mode requires that a match occur between the Sync Code Register and one incoming character before data transfer to the FIFO begins. The two-sync-character mode requires that two sync codes be received in sequence to establish synchronization. Subsequent to synchronization in any mode, data is accumulated in the shift register, and parity is optionally checked. An indication of parity error is carried through the Receiver FIFO with each character to the last empty location. Availability of a word at the FIFO output is indicated by the RDA status bit in the Status Register, as is a parity error (PE)

The SSDA and its internal registers are selected by RS, $\overline{\text{CS}}$, Read/Write (R/ $\overline{\text{W}}$) and Enable control lines. To configure the SSDA, Control Registers are selected and the appropriate bits set. The Status Register is addressable for reading status.

Other I/O lines, in addition to Clear-to-Send (CTS) and Data Carrier Detect (DCD), include SM/DTR (Sync Match/Data Terminal Ready) and Transmitter Underflow (TUF). The transmitter and receiver each have individual clock inputs allowing simultaneous operation under separate clock control. Signals to the microprocessor are the Data Bus and Interrupt Request (IRQ).

INITIALIZATION

During a power-on sequence, the SSDA is reset via the RESET input and internally latched in a reset condition to prevent erroneous output transitions. The Receiver Shift Register is set to all "1's". The Sync Code Register, Control Register 2, and Control Register 3 should be programmed prior to the programmed release of the Transmitter and/or Receiver Reset bits; these bits in Control Register 1 should be cleared after the RESET line has gone high.

TRANSMITTER OPERATION

Data is transferred to the transmitter section in parallel form by means of the data bus and Transmit Data FIFO. The Transmit Data FIFO is a 3-byte register whose status is indicated by the Transmitter Data Register Available status bit (TDRA) and its associated interrupt enable bit Data is transferred through the FIFO on negative edges of Enable (E) pulses. Two data transfer modes are provided in the SSDA. The 1-byte transfer mode provides for writing data to the transmitter section (and reading from the receiver section) one byte at a time. The 2-byte transfer mode provides for writing two data characters in succession.

Data will automatically transfer from the last register location in the Transmit Data FIFO (when it contains data) to the Transmitter Shift Register during the last half of the last bit of the previous character. A character is transferred into the Shift Register by the Transmitter Clock. Data is transmitted LSB first, and odd or even parity can be optionally appended. The unused bit positions in short word length characters, from the data bus, are "don't cares" (Note. The data bus inputs may be reversed for applications requiring the MSB to be transferred first, e.g., IBM format for floppy disks, however, care must be taken to properly program the control registers. — Table 1 will have its bit positions reversed.)

When the Shift Register becomes empty, and data is not available for transfer from the Transmit Data FIFO, an "underflow" occurs, and a character is inserted into the transmitter data stream to maintain character synchronization. The character transmitted on underflow will be either a "Mark" (all "1's") or the contents of the Sync Code Register, depending upon the state of the Transmit Sync Code on Underflow control bit The underflow condition is indicated by a pulse (=1 Tx CLK high period) on the Underflow output (when in Tx Sync on underflow mode) The Underflow output occurs coincident with the transfer of the last half of the last bit preceding the underflow character The Underflow status bit is set until cleared by means of the Clear Underflow control bit This output may be used in floppy disk systems to synchronize write operations and for appending CRCC

Transmission is initiated by clearing the Transmitter Reset bit in Control Register 1. When the Transmitter Reset bit is cleared, the first *full* positive half-cycle of the Transmit Clock will initiate the transmit cycle, with the transmission of data or underflow characters beginning on the negative edge of the Transmit Clock pulse which started the cycle. If the Transmit Data FIFO was not loaded, an underflow character will be transmitted (see Figure 4).

The Clear-to-Send (CTS) input provides for automatic control of the transmitter by means of external system hardware; e.g., the modem CTS output provides the control in a data communications system. The CTS input resets and inhibits the transmitter section when high, but does not reset the Transmit Data FIFO. The TDRA status bit is inhibited by CTS being high in either the one-sync character or two-sync character mode of operation. In the external sync mode, TDRA is unaffected by CTS in order to provide Transmit Data FIFO status for preloading and operating the transmitter under the control of the CTS input. When the Transmitter Reset bit (Tx Rs) is set, the Transmit Data FIFO is cleared and the TDRA status bit is cleared. After one E clock has occurred, the Transmit Data FIFO becomes available for new data with TDRA inhibited.

RECEIVER OPERATION

Data and a presynchronized clock are provided to the SSDA receiver section by means of the Receive Data (Rx Data) and Receive Clock (Rx CLK) inputs. The data is a continuous stream of binary data bits without means for identifying character boundaries within the stream. It is, therefore, necessary to achieve character synchronization for the data at the *beginning* of the data block. Once synchronization is achieved, it is assumed to be retained for all successive characters within the block.

Data communications systems utilize the detection of sync codes during the initial portion of the preamble to establish character synchronization. This requires the detection of a single code or two successive sync codes. Fioppy disk and cartridge tape units require sixteen bits of defined preamble and cassettes require eight bits of preamble to establish the reference for the start of record. All three are functionally equivalent to the detection of sync codes. Systems which do not utilize code detection techniques require custom logic external to the SSDA for character synchronization and use of the parallel-to-serial (external sync) mode. (Note: The Receiver Shift Register is set to ones when reset.)

SYNCRHONIZATION

The SSDA provides three operating modes with respect to character synchronization one-sync-character mode, twosync-character mode, and external sync mode. The external sync mode requires synchronization and control of the receiving section through the Data Carrier Detect (DCD) input (see Figure 7) This external synchronization could consist of direct line control from the transmitting end of the serial data link or from external logic designed to detect the start of the message block. The one-sync-character mode searches on a bit-by-bit basis until a match is achieved between the data in the Shift Register and the Sync Code Register The match indicates character synchronization is complete and will be retained for the message block. In the two-sync-character mode, the receiver searches for the first sync code match on a bit-by-bit basis and then looks for a second successive sync code character prior to establishing character synchronization. If the second sync code character is not received, the bit-by-bit search for the first sync code is resumed

Sync codes received prior to the completion of synchronization (one or two character) are not transferred to the Receive Data FIFO Redundant sync codes during the preamble or sync codes which occur as "filli characters" can automatically be stripped from the data, when the Strip Sync control bit is set, to minimize system loading. The character synchronization will be retained until cleared by means of the Clear Sync bit, which also inhibits synchronization search when set

RECEIVING DATA

Once synchronization has been achieved, subsequent characters are automatically transferred into the Receive Data FIFO and clocked through the FIFO to the last empty location by E pulses (MPU System \$\phi2\$) The Receiver Data Available status bit (RDA) indicates when data is available to be read from the last FIFO location (\$\frac{x}{4}\$) when in the 1-byte transfer mode. The 2-byte transfer mode causes the RDA status bit to indicate data is available when the last two FIFO

register locations are full. Data being available in the Receive Data FIFO causes an interrupt request if the Receiver Interrupt Enable (RIE) bit is set. The MPU will then read the SSDA Status Register which will indicate that data is available for the MPU read from the Receive Data FIFO register. The IRQ and RDA status bits are reset by a read from the FIFO. If more than one character has been received and is resident in the Receive Data FIFO, subsequent E clocks will cause the FIFO to update and the RDA and IRQ status bits will again be set. The read data operation for the 2-byte transfer mode requires an intervening E clock between reads to allow the FIFO data to shift Optional parity is automatically checked as data is received, and the parity status condition is maintained with each character until the data is read from the Receive Data FIFO Parity errors will cause an interrupt request if the Error Interrupt Enable (EIE) has been set. The parity bit is not transferred to the data bus but must be checked in the Status Register NOTE In the 2-byte transfer mode, parity should be checked prior to reading the second byte, since a FIFO read clears the error

Other status bits which pertain to the receiver section are Receiver Overrun and Data Carrier Detect (DCD). The Overrun status bit is automatically set when a transfer of a character to the Receive Data FIFO occurs and the first register of the Receive Data FIFO is full. Overrun causes an interrupt if Error Interrupt Enable (EIE) has been set. The transfer of the overrunning character into the FIFO causes the previous character in the FIFO input register location to be lost. The Overrun status bit is cleared by reading the Status Register (when the overrun condition is present), followed by a Receive data FIFO Register read. Overrun cannot occur and be cleared without providing an opportunity to detect its occurrence via the Status Register.

A positive transition on the \overline{DCD} input causes an interrupt if the EIE control bit has been set. The interrupt caused by \overline{DCD} is cleared by reading the Status Register when the \overline{DCD} status bit is high, followed by a Receive data FIFO read. The \overline{DCD} status bit will subsequently follow the state of the \overline{DCD} input when it goes low

INPUT/OUTPUT FUNCITONS

SSDA INTERFACE SIGNALS FOR MPU

The SSDA interfaces to the MC6800 MPU with an 8-bit bidirectional data bus, a chip-select line, a register-select line, an interrupt-request line, read/write line, an enable line, and a reset line. These signals, in conjunction with the MC6800 VMA output, permit the MPU to have complete control over the SSDA.

SSDA Bi-Directional Data (D0-D7) — The bi-directional data lines (D0-D7) allow for data transfer between the SSDA and the MPU. The data bus output drivers are three-state devices that remain in the high-impedance (off) state except when the MPU performs an SSDA read operation.

SSDA Enable (E) — The Enable signal, E, is a high-impedance TTL-compatible input that enables the bus input/output data buffers, clocks data to and from the SSDA, and moves data through the FIFO Registers

Read/Write (R/\overline{W}) — The Read/Write line is a high-impedance input that is TTL compatible and is used to control the direction of data flow through the SSDA's input/output data bus interface. When Read/Write is high (MPU read cycle), SSDA output drivers are turned on if the chip is selected and a selected register is read. When it is low, the SSDA output drivers are turned off and the MPU writes into a selected register. The Read/Write signal is also used to select read-only or write-only registers within the SSDA.

Chip Select (\overline{CS}) — This high-impedance TTL-compatible input line is used to address the SSDA. The SSDA is selected when \overline{CS} is low VMA should be used in generating the \overline{CS} input to insure that false selects will not occur Transfers of data to and from the SSDA are then performed under the control of the Enable signal, Read/Write, and Register Select

Register Select (RS) — The Register Select line is a high-impedance input that is TTL compatible. A high level is used to select Control Registers C2 and C3, the Sync Code Register, and the Transmit/Receive Data Registers. A low level selects the Control 1 and Status Registers (see Table 1)

Interrupt Request (IRQ) — Interrupt Request is a TTL compatible, open-drain (no internal pullup), active low output that is used to interrupt the MPU. The Interrupt Request remains low until cleared by the MPU.

RESET Input — The $\overline{\text{RESET}}$ input provides a means of resetting the SSDA from an external source. In the low state, the $\overline{\text{RESET}}$ input causes the following

- 1 Receiver Reset (Rx Rs) and Transmitter Reset (Tx Rs) bits are set causing both the receiver and transmitter sections to be held in a reset condition
- 2 Peripheral Control bits PC1 and PC2 are reset to zero, causing the SM/DTR output to be high
- 3 The Error Interrupt Enable (EIE) bit is reset
- 4 An internal synchronization mode is selected
- The Transmitter Data Register Available (TDRA) status bit is cleared and inhibited
- 6 The Receiver Shift Register is set to 1's

When RESET returns high (the inactive state), the transmitter and receiver sections will remain in the reset state until the Receiver Reset and Transmitter Reset bits are cleared via the data bus under software control. The control Register bits affected by RESET (Rx Rs, Tx Rs, PC1, PC2, EIE, and E/I Sync) cannot be changed when RESET is low.

CLOCK INPUTS

Separate high-impedance TTL-compatible inputs are provided for clocking of transmitted and received data.

Transmit Clock (Tx CLK) — The Transmit Clock input is used for the clocking of transmitted data. The transmitter shifts data on the negative transition of the clock

Receive Clock (Rx CLK) — The Receive Clock input is used for clocking in received data. The clock and data must be synchronized externally. The receiver samples the data on the positive transition of the clock.

SERIAL INPUT/OUTPUT LINES

Receive Data (Rx Data) — The Receive Data line is a highimpedance TTL-compatible input through which data is received in a serial format

Transmit Data (Tx Data) – The Transmit Data output line transfers serial data to a modem or other peripheral.

PERIPHERAL/MODEM CONTROL

The SSDA includes several functions that permit limited control of a peripheral or modem. The functions included are Clear-to-Send, Sync Match/Data Terminal Ready, Data Carrier Detect, and Transmitter Underflow.

Clear-to-Send ($\overline{\text{CTS}}$) — The $\overline{\text{CTS}}$ input provides a real-time inhibit to the transmitter section (the Tx Data FIFO is not disturbed). A positive $\overline{\text{CTS}}$ transition resets the Tx Shift Register and inhibits the TDRA status bit and its associated interrupt in both the one-sync-character and two-sync-character modes of operation. TDRA is not affected by the $\overline{\text{CTS}}$ input in the external sync mode

The positive transition of $\overline{\text{CTS}}$ is stored within the SSDA to insure that its occurrence will be acknowledged by the system. The stored $\overline{\text{CTS}}$ information and its associated $\overline{\text{RO}}$ (if enabled) are cleared by writing a "11" in the Clear $\overline{\text{CTS}}$ bit in Control Register 3 or in the Transmitter Reset bit $\overline{\text{The CTS}}$ status bit subsequently follows the $\overline{\text{CTS}}$ input when it goes low

The CTS input provides character timing for transmitter data when in the external sync mode. Transmission is intuated on the negative transition of the first *full* positive clock pulse of the transmitter clock (Tx CLK) after the release of CTS (see Figure 6).

Data Carrier Detect (DCD) — The DCD input provides a real-time inhbit to the receiver section (the Rx FIFO is not disturbed). A positive DCD transition resets and inhibts the receiver section except for the Receive FIFO and the RDRA status bit and its associated IRQ

The positive transition of \overline{DCD} is stored within the SSDA to insure that its occurrence will be acknowledged by the system. The stored \overline{DCD} information and its associated \overline{IRQ} (if enabled) are cleared by reading the Status Register and then the Receiver FIFO, or by writing a ''1'' into the Receiver Reset bit. The \overline{DCD} status bit subsequently follows the \overline{DCD} input when it goes low. The \overline{DCD} input provides character synchronization timing for the receiver during the external sync mode of operation. The receiver will be initialized and data will be sampled on the positive transition of the first full. Receive Clock cycle after release of \overline{DCD} (see Figure 7)

Sync Match/Data Terminal Ready (SM/ $\overline{\text{DTR}}$) — The SM/DTR output provides four functions (see Table 1) depending on the state of the PC1 and PC2 control bits When the Sync Match mode is selected (PC="1", PC2="0"), the output provides a one-bit-wide pulse when a sync code is detected. This pulse occurs for each sync code match even if the receiver has already attained synchronization. The SM output is inhibited when PC2="1". The $\overline{\text{DTR}}$ mode (PC1="0") provides an output level corresponding to the complement of PC2 ($\overline{\text{DTR}}$ ="0" when PC2="1") (See Table 1.)

TABLE 1 - SSDA PROGRAMMING MODEL

| Register | 1 | ntrol puts | | dress ntrol | | | | R | egister Conte | nt | | |
|-----------------------|----|---------------|-----|----------------|---------------------------------------|---|--|---|---|--|---|---|
| | RS | R/W | AC2 | AC1 | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 |
| Status (S) | 0 | 1 | × | X | Interrupt Request (IRQ) | Receiver Parity Error (PE) | Receiver Overrun (Rx Ovrn) | Transmitter Underflow (TUF) | Clear-to- Send (CTS) | Data Carrier Detect (DCD) | Transmitter Data Register Available (TDRA) | Receiver Data Available (RDA) |
| Control 1 (C1) | 0 | 0 | × | × | Address Control 2 (AC2) | Address Control 1 (AC1) | Receiver Interrupt Enable (RIE) | Transmitter Interrupt Enable (TIE) | Clear Sync | Strip Sync Characters (Strip Sync) | Transmitter Reset (Tx Rs) | Receiver Reset (Rx Rs) |
| Receive Data FIFO | 1 | 1 | × | × | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
| Control 2 (C2) | 1 | 0 | 0 | 0 | Error Interrupt Enable (EIE) | Transmit Sync Code on Underflow (Tx Sync) | Word Length Select 3 (WS3) | Word Length Select 2 (WS2) | Word Length Select 1 (WS1) | 1-Byte/2-Byte Transfer (1-Byte/2 Byte) | Peripheral Control 2 (PC2) | Peripheial Control 1 (PC1) |
| Control 3 (C3) | 1 | 0 | 0 | 1 | Not Used | Not Used | Not Used | Not Used | Clear Transmitter Underflow Status (CTUF) | Clear CTS Status (Clear CTS) | One-Sync- Character/ Two-Sync Character Mode Control (1 Sync/ 2 Sync) | External/ Internal Sync Mode Control (E/I Sync) |
| Sync Code | 1 | 0 | 1 | 0 | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
| Transmit Data FIFO | 1 | 0 | 1 | 1 | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |

X = Don't care

STATUS REGISTER

IRQ Bit 7 The IRQ flag is cleared when the source of the IRQ is cleared. The source is determined by the enables in the Control Registers TIE, RIE, EIE

Bits 6-0 indicate the SSDA status at a point in time, and can be reset as follows

PE Bit 6 Read Rx Data FIFO, or a "1" into Rx Rs (C1 Bit 0) Rx Ovrn Bit 5 Read Status and then Rx Data FIFO, or a "1" into

Rx Rs (C1 Bit 0)

TUF Bit 4 A "1" into CTUF (C3 Bit 3) or into Tx Rs (C1 Bit 1)

CTS Bit 3 A "1" into Clear CTS (C3 Bit 2) or a "1" into Tx Rs

DCD Bit 2 Read Status and then Rx Data FIFO or a "1" into Rx Rs (C1 Bit 0)

TDRA Bit 1 Write into Tx Data FIFO RDA Bit 0 Read Rx Data FIFO.

(C1 Bit1)

CONTROL REGISTER 1

AC2, AC1 Bit 5 7, 6 Used to access other registers, as shown above RIE Bit 5 When "1", enables interrupt on RDA (S Bit 0)

Clear Sync Bit 4 When "1", enables interrupt on TDRA (S Bit 1)

Clear Sync Bit 3 When "1", clears receiver character synchronization

Strip Sync Bit 2 When "1", strips all sync codes from the received data stream

Tx Rs Bit 1 When "1", resets and inhibits the transmitter section

Rx Rs Bit 0 When "1", resets and inhibits the receiver section

CONTROL REGISTER 3

CTUF Bit 3 When "1", clears TUF (S Bit 4), and IRQ if enabled Clear CTS Bit 2 When "1", clears CTS (S Bit 3), and IRQ if enabled 1 Sync/2 Sync Bit 1 When "1", selects the one-sync-character mode, when "0", selects the two-sync-character mode when "0", selects the two-sync-character mode when "0", selects the two-sync-character mode when "0".

E/I Sync Bit 0 When "1", selects the external sync mode, when "0", selects the internal sync mode

CONTROL REGISTER 2

WS3, 2, 1

EIE Bit 7 When "1", enables the PE, Rx Ovrn,
TUF, CTS, and DCD interrupt flags
(\$ Bits 6 th.ough 2)

Tx Sync Bit 6 When "1", allows sync code contents to be transferred on underflow, and enables the TUF Status bit and output. When "0", an all mark character

is transmitted on underflow Bits 5-3 Word Length Select

| Bit 5 WS3 | Bit 4 WS2 | | Word Length |
|--------------|--------------|---|----------------------|
| 0 | 0 | 0 | 6 Bits + Even Parity |
| 0 | 0 | 1 | 6 Bits + Odd Parity |
| 0 | 1 | 0 | 7 Bits |
| 0 | 1 | 1 | 8 Bits |
| 1 | 0 | 0 | 7 Bits + Even Parity |
| 1 | 0 | 1 | 7 Bits + Odd Parity |
| 1 | 1 | 0 | 8 Bits + Even Parity |
| 1 | 1 | 1 | 8 Bits + Odd Parity |

1-Byte/2-Byte Bit 2 When "1", enables the TDRA and RDA bits to indicate when a 1-byte transfer can occur, when "0", the TDRA and RDA bits indicate when

a 2-byte transfer can occur PC2, PC1 Bits 1-0 SM/DTR Output Control

| Bit 1 PC2 | Bit 0 PC1 | SM/DTR Output at Pin 5 |
|--------------|--------------|--------------------------|
| 0 | 0 | Pulse, 1 Bit Wide, on SM |
| 1 | 0 | 0 |
| 1 | 1 | SM Inhibited, 0 |

NOTE When the SSDA is used in applications requiring the MSB of data to be received and transmitted first, the data bus inputs to the SSDA may be reversed (D0 to D7, etc.) Caution must be used when this is done since the bit positions in this table will be reversed, and the parity should not be selected.

Transmitter Underflow (TUF) — The Underflow output indicates the occurrence of a transfer of a "fill character" to the Transmitter Shift Register when the last location (#3) in the Transmit Data FIFO is emtpy. The Underflow output pulse is approximately one Tx CLK high period wide and occurs during the last half of the last bit of the character preceding the "Underflow" (see Figure 4). The Underflow output pulse does not occur when the Tx Sync bit is in the reset state.

SSDA REGISTERS

Seven registers in the SSDA can be accessed by means of the data bus. The registers are defined as read-only or write-only according to the direction of information flow The Register Select input (RS) selects two registers in each state, one being read-only and the other write-only. The Read/Write input (R/W) defines which of the two selected registers will actually be accessed. Four registers (two read-only and two write-only) can be accessed via the bus at any particular time. These registers and the required addressing are defined in Table 1.

CONTROL REGISTER 1 (C1)

Control Register 1 is an 8-bit write-only register that can be directly addressed from the data bus. Control Register 1 is accessed when RS = "0" and R/\overline{W} = "0".

Receiver Reset (Rx Rs), C1 Bit 0 — The Receiver Reset control bit provides both a reset and inhibit function to the receiver section. When Rx Rs is set, it clears the receiver control logic, sync logic, error logic, Rx Data FIFO Control, Parity Error status bit, and DCD interrupt. The Receiver Shift Register is set to ones. The Rx Rs bit must be cleared after the occurrence of a low level on RESET in order to enable the receiver section of the SSDA.

Transmitter Reset (Tx Rs), C1 Bit 1 — The Transmitter Reset control bit provides both reset and inhibit to the transmitter section. When Tx Rs is set, it clears the transmitter control section, Transmitter Shift Register, Tx Data FIFO Control (the Tx Data FIFO can be reloaded after one E clock pulse), the Transmitter Underflow status bit, and the $\overline{\text{CTS}}$ interrupt, and inhibits the TDRA status bit (in the one-sync-character and two-sync-character modes) The Tx Rs bit must be cleared after the occurrence of a low level on $\overline{\text{RESET}}$ in order to enable the transmitter section of the SSDA. If the Tx FIFO is not preloaded, it must be loaded immediately after the Tx Rs release to prevent a transmitter underflow condition.

Strip Synchronization Characters (Strip Sync), C1 Bit 2—
If the Strip Sync bit is set, the SSDA will automatically strip
all received characters which match the contents of the Sync
Code Register The characters used for synchronization (one
or two characters of sync) are always stripped from the
received data stream

Clear Synchronization (Clear Sync), C1 Bit 3 — The Clear Sync control bit provides the capability of dropping receiver character synchronization and inhibiting resynchronization. The Clear Sync bit is set to clear and inhibit receiver synchronization in all modes and is reset to zero to enable resynchronization.

Transmitter Interrupt Enable (TIE), C1 Bit 4 - TIE enables both the Interrupt Request output ($\overline{\text{IRQ}}$) and Interrupt Request status bit to indicate a transmitter service request When TIE is set and the TDRA status bit is high, the $\overline{\text{IRQ}}$ output will go low (the active state) and the $\overline{\text{IRQ}}$ status bit will go high

Receiver Interrupt Enable (RIE), C1 Bit 5 — RIE enables both the Interrupt Request output $\overline{(IRQ)}$ and the Interrupt Request starus bit to indicate a receiver service request. When RIE is set and the RDA status bit is high, the \overline{IRQ} output will go low (the active state) and the \overline{IRQ} status bit will go high

Address Control 1 (AC1) and Address Control 2 (AC2), C1 Bits 6 and 7 — AC1 and AC2 select one of the write-only registers — Control 2, Control 3, Sync Code, or Tx Data FIFO — as shown in Table 1, when RS="1" and R/W="0"

CONTROL REGISTER 2 (C2)

Control Register 2 is an 8-bit write-only register which can be programmed from the data bus when the Address Control bits in Control Register 1 (AC1 and AC2) are reset, RS = "1" and R/W="0"

Peripheral Control (PC1) and Peripheral Control 2 (PC2), C2 Bits 0 and 1 — Two control bits, PC1 and PC2, determine the operating characteristics of the Sync Match/ \overline{DTR} output PC1, when high, selects the Sync Match mode PC2 provides the inhibit/enable control for the SM/\overline{DTR} output in the Sync Match mode A one-bit-wide pulse is generated at the output when PC2 is "0", and a match occurs between the contents of the Sync Code Register and the incoming data even if sync is inhibited (Clear Sync bit="1") The Sync Match pulse is referenced to the negative edge of Rx-CLK pulse causing the match (see Figure 3)

The Data Terminal Ready (DTR) mode is selected when PC1 is low When PC2="'1" the SM/DTR output="'0" and vice versa. The operation of PC2 and PC1 is summarized in Table 1.

1-Byte/2-Byte Transfer (1-Byte/2-Byte), C2, Bit 2 — When 1-Byte/2-Byte is set, the TDRA and RDA status bits will indicate the availability of their respective data FIFO registers for a single-byte data transfer Alternately, if 1-Byte/2-Byte is reset, the TDRA and RDA status bits indicate when two bytes of data can be moved without a second status read. An intervening Enable pulse must occur between data transfers

Word Length Selects (WS1, WS2, WS3), C2 Bits 3, 4, 5 — Word Length Select bits WS1, WS2, and WS3 select word lengths of 7, 8, or 9 bits including parity as shown in Table 1

Transmit Sync Code on Underflow (Tx Sync), C2 Bit 6 — When Tx Sync is set, the transmitter will automatically send a sync character when data is not available for transmission if Tx Sync is reset, the transmitter will transmit a Mark character (including the parity bit position) on underflow When the underflow is detected, a pulse approximately one Tx CLK high period wide will occur on the underflow output

If the Tx Sync bit is set. Internal parity generation is inhibited during underflow except for sync code fill character transmission in 8-bit plus parity word lengths.

Error Interrupt Enable (EIE), C2 Bit 7- When EIE is set, the $\overline{\text{IRQ}}$ status bit will go high and the $\overline{\text{IRQ}}$ output will go low if

- 1 A receiver overrun occurs The interrupt is cleared by reading the Status Register and reading the Rx Data
- 2 DCD input has gone to a "1" The interrupt is cleared by reading the Status Register and reading the Rx Data FIFO
- 3 A parity error exists for the character in the last location (#3) of the Hx Data FIFO The interrupt is cleared by reading the Rx Data FIFO
- The CTS input has gone to a "1" The interrupt is cleared by writing a "1" in the Clear CTS bit, C3 bit 2, or by a Tx Reset
- 5 The transmitter has underflowed (in the Tx Sync on Underflow mode) The interrupt is cleared by writing a "1" into the Clear Underflow, C3 bit 3, or Tx Reset

When EIE is a "0", the \overline{IRQ} status bit and the \overline{IRQ} output are disabled for the above error conditions. A low level on the \overline{RESET} input resets EIE to "0"

CONTROL REGISTER 3 (C3)

Control Register 3 is a 4-bit write-only register which can be programmed from the data bus whe RS="1" and R/ \overline{W} ="0" and Address Control bit AC1="1" and AC2="0"

External/Internal Sync Mode Conrol (E/I Sync), C3, Bit 0 — When the E/I Sync Mode bit is high, the SSDA is in the external sync mode and the receiver synchronization logic is disabled Synchronization can be achieved by means of the $\overline{\rm DCD}$ input or by starting Rx CLK at the midpoint of data bit 0 of a cahracter with $\overline{\rm DCD}$ low. Both the transmitter and receiver sections operate as parallel — serial converters in the External Sync mode. The Clear Sync bit in Control Register 1 acts as a receiver sync inhibit when high to provide a bus controllable inhibit. The Sync Code Register can serve as a transmitter fill character register and a receiver match register in this mode. A "low" on the RESET input resets the E/I Sync Mode bit placing the SSDA in the internal sync mode.

One-Sync-Character/Two-Sync-Character Mode Control (1-Sync/2-Sync), C3 Bit 1 — When the 1-Sync/2-Sync bit is set, the SSDA will synchronize on a single match between the received data and the contents of the Sync Code Register When the 1-Sync/2-Sync bit is reset, two successive sync characters must be received prior to receiver synhichronization. If the second sync character is not detected, the bit-by-bit search resumes from the first bit in the second character. See the description of the Sync Code Register for more details.

Clear $\overline{\text{CTS}}$ Status (Clear $\overline{\text{CTS}}$), C3 Bit 2 — When a "1" is written into the Clear $\overline{\text{CTS}}$ bit, the stored status and interrupt are cleared Subsequently, the $\overline{\text{CTS}}$ status bit reflects the

state of the $\overline{\text{CTS}}$ input. The Clear $\overline{\text{CTS}}$ control bit does not affect the $\overline{\text{CTS}}$ input nor its inhibit of the transmitter section. The Clear $\overline{\text{CTS}}$ command bit is self-clearing, and writing a "0" into this bit is a nonfunctional operation.

Clear Transmit Underflow Status (CTUF), C3 Bit 3 — When a "1" is written into the CTUF status bit, the CTUF bit and its associated interrupt are reset. The CTUF command bit is self-clearing and writing a "0" into this bit is a nonfunctional operation

SYNC CODE REGISTER

The Sync Code Register is an 8-bit register for storing the programmable sync code required for received data character synchronization in the one-sync-character and two-sync-character modes. The Sync Code Register also provides for stripping the sync/fill characters from the received data (a programmable option) as well as automatic insertion of fill characters in the transmitted data stream. The Sync Code Register is not utilized for receiver character synchronization in the external sync mode, however, it provides storage of receiver match and transmit fill characters.

The Sync Code Register can be loaded when AC2 and AC1 are a "1" and "0", respectively, and R/W="0" and RS="1"

The Sync Code Register may be changed after the detection of a match with the received data (the first sync code having been detected) to synchronize with a double-word sync pattern. (This sync code change must occur prior to the completion of the second character.) The sync match (SM) output can be used to interrupt the MPU system to indicate that the first eight bits have matched. The service routine would then change the sync match register to the second half of the pattern. Alternately, the one-sync-character mode can be used for sync codes for 16 or more bits by using software to check the second and subsequent bytes after reading them from the FIFO.

The detection of the sync code can be programmed to appear on the Sync Match/DTR output by writing a "1" in PC1 (C2 bit 0) and a "0" in PC2 (C2 bit 1). The Sync Match output will go high for one bit time beginning at the character interface between the sync code and the next character (see Figure 3).

PARITY FOR SYNC CHARACTER

Transmitter

Transmitter does not generate parity for the sync character except 9-bit mode

9-bit (8-bit + parity) 8-bit sync character + parity 8-bit (7-bit + parity) 8-bit sync character (no parity) 7-bit (6-bit + parity). 7-bit sync character (no parity)

Receiver

At Synchronization

Receiver automatically strips the sync character(s) (two sync characters if '2 sync' mode is selected) which is used to establish synchronization Parity is not checked for these sync characters.

After Synchronization Is Established

When 'strip sync' bit is selected, the sync characters (fill characters) are stripped and parity is not checked for the stripped sync (fill) characters. When "strip sync" bit is not selected (low), the sync character is assumed to be normal data and it is transferred into FIFO after parity checking (When non-parity format is selected, parity is not checked.)

| Strip Sync (C1, Bit 2) | WS0-WS2 (Data Format) (C2, Bits 3-5) | |
|---------------------------|--|--|
| 1 | х | No transfer of sync code No parity Check of sync code |
| 0 | With Parity | *Transfer data and sync codes Parity check |
| 0 | Without Panty | *Transfer data and sync codes No parity check |

^{*}Subsequent to synchronization

It is necessary to consider parity in the selected sync character in the following cases Data Format is (6+ parity), (7+ parity), strip sync is not selected (low), and when syric code is used as a fill character after synchronization

The transmitter sends a sync character without parity, but the receiver checks the parity as if it is normal data. Therefore, the sync character should be chosen to match the parity check selected for the receiver in this special case. See the following section for unused bit assignment in shortword length.

RECEIVE DATA FIRST-IN FIRST-OUT REGISTER (Rx Data FIFO)

The Receive Data FIFO Register consists of three 8-bit registers which are used for buffer storage of received data. Each 8-bit register has an internal status bit which monitors its full or empty condition. Data is always transferred from a full register to an adjacent empty register. The transfer from register to register occurs on E pulses. The RDA status bit will be high when data is available in the last location of the Rx Data FIFO.

In an Overrun condition, the overrunning character will be transferred into the full first stage of the FIFO register and will cause the loss of that data character. Successive overruns continue to overwrite the first register of the FIFO. This destruction of data is indicated by means of the Overrun status bit. The Overrun bit will be set when the overrun occurs and remains set until the Status Register is read, followed by a read of the Rx Data FIFO.

Unused data bits for short word lengths (including the parity bit) will appear as "0's" on the data bus when the Rx Data FIFO is read

TRANSMIT DATA FIRST-IN FIRST-OUT REGISTER (Tx Data FIFO)

The Transmit Data FIFO Register consists of thee 8-bit registers which are used for buffer storage of data to be transmitted Each 8-bit register has an internal status bit which monitors its full or empty condition. Data is always transferred from a full register to an adjacent empty register. The transfer is clocked by E pulses

The TDRA status bit will be high if the Tx Data FIFO is available for data

Unused data bits for short word lengths will be handled as "don't cares." The parity bit is not transferred over the data bus since the SSDA generates parity at transmission.

When an Underflow occurs, the Underflow character will be either the contents of the Sync Code Register or an all "11's" character. The underflow will be stored in the Status Register until cleared and will appear on the Underflow output as a pulse approximatley one Tx CLK high period wide

STATUS REGISTER (S)

The Status Register is an 8-bit read-only register which provides the real-time status of the SSDA and the associated serial data channel. Reading the Status Register is a non-destructive process. The method of clearing status bits depends upon the function each bit represents and is discussed for each bit in the register.

Receiver Data Available (RDA), S Bit 0 — The Receiver Data Available status bit indicates when receiver data can be read from the Rx Data FIFO. The receiver data being present in the last register (#3) of the FIFO causes RDA to be high for the 1-byte transfer mode. The RDA bit being high indicates that the last two registers (#2 and #3) are full when in the 2-byte transfer mode. The second character can be read without a second status read (to determine that the character is available). An E pulse must occur between reads of the Rx Data FIFO to allow the FIFO to shift. Status must be read on a word-by-word basis if receiver data error checking is important. The RDA status bit is reset automatically when data is not available.

Transmitter Data Register Available (TDRA), S Bit 1 -The TDRA status bit indicates that data can be loaded into the Tx Data FIFO Register The first register (#1) of the Tx Data IFFO being empty will be indicated by a high level in the TDRA status bit in the 1-byte transfer mode. The first two registers (#1 and #2) must be empty for TDRA to be high when in the 2-byte transfer mode. The Tx Data FIFO can be loaded with two bytes without an intervening status read, however, one E pulse must occur between loads TDRA is inhibited by the Tx Reset or RESET. When Tx Reset is set, the Tx Data FIFO is cleared and then released on the next E clock pulse. The Tx Data FIFO can then be loaded with up to three characters of data, even though TDRA is inhibited This feature allows preloading data prior to the release of Tx Reset A high level on the CTS input inhibits the TDRA status bit in either sync mode of operation (one-synccharacter or two-sync-character) CTS does not affect TDRA in the external sync mode. This enables the SSDA to operate under the control of the CTS input with TDRA indicating the status of the Tx Data FIFO. The CTS input does not clear the Tx Data FIFO in any operating mode

Data Carrier Detect (\overline{DCD}), S Bit 2 — A positive transition on the DCD input is stored in the SSDA until cleared by reading both Status and Rx Data FIFO A "1" written into Rx Rs also clears the stored \overline{DCD} status. The \overline{DCD} status bit, when set, indicates that the \overline{DCD} input has gone high. The reading of Status followed by reading of the Receive Data FIFO allows Bit 2 of subsequent Status reads to indicate the state of the \overline{DCD} input until the next positive transition

Clear-to-Send ($\overline{\text{CTS}}$), S Bit 3 — A positive transition on the $\overline{\text{CTS}}$ input is stored in the SSDA until cleared by writing a "1" into the Clear $\overline{\text{CTS}}$ control bit or the $\overline{\text{Tx}}$ Rs bit. The $\overline{\text{CTS}}$ status bit, when set, indicates that the $\overline{\text{CTS}}$ input has gone high. The Clear $\overline{\text{CTS}}$ command (a "1" into C3 Bit 2) allows Bit 3 of subsequent Status reads to indicate the state of the $\overline{\text{CTS}}$ input until the next positive transition

Transmitter Underflow (TUF), S Bit 4 — When data is not available for the transmitter, an underflow occurs and is so indicated in the Status Register (in the Tx Sync on underflow mode). The underflow status bit is cleared by writing a "1" into the Clear Underflow (CTUF) control bit or the Tx Rs bit TUF indicates that a sync character will be transmitted as the next character. A TUF is indicated on the output *only* when the contents of the Sync Code Register is to be transferred (transmit sync code on underflow = "1").

Receiver Overrun (Rx Ovrn), S Bit 5 — Overrun indicates data has been received when the Rx Data FIFO is full.

resulting in data loss. The Rx Ovrn status bit is set when overrun occurs. The Rx Ovrn status bit is cleared by reading. Status followed by reading the Rx Data FIFO or by setting the Rx Rs control bit.

Receiver Parity Error (PE), S Bit 6 — The parity error status bit indicates that parity for the character in the last register of the Rx Data FIFO did not agree with selected parity. The parity error is cleared when the character to which it pertains is read from the Rx Data FIFO or when Rx Rs occurs. The DCD input does not clear the Parity Error or Rx Data FIFO status bits.

Interrupt Request (\overline{IRQ}), S Bit 7 — The Interrupt Request status bit indicates when the \overline{IRQ} output is in the active state (\overline{IRQ} output = "0"). The \overline{IRQ} status bit is subject to the same interrupt enables (RIE, TIE, and EIE) as the \overline{IRQ} output. The \overline{IRQ} status bit simplifies status inquiries for polling systems by providing single bit indication of service requests



MC6854 (1.0 MHz) MC68A54 (1.5 MHz) MC68B54 (2.0 MHz)

ADVANCED DATA-LINK CONTROLLER (ADLC)

The MC6854 ADLC performs the complex MPU/data communication link function for the "Advanced Data Communication Control Procedure" (ADCCP), High-Level Data-Link Control (HDLC) and Synchronous Data-Link Control (SDLC) standards. The ADLC provides key interface requirements with improved software efficiency. The ADLC is designed to provide the data communications interface for both primary and secondary stations in stand-alone, polling, and loop configurations.

- M6800 Compatible
- Protocol Features
 - Automatic Flag Detection and Synchronization
 - Zero Insertion and Deletion
 - Extendable Address, Control and Logical Control Fields (Optional)
 - Variable Word Length Information Field 5-, 6-, 7-, or 8-Bits
 - Automatic Frame Check Sequence Generation and Check
 - Abort Detection and Transmision
 - Idle Detection and Transmission
- Loop Mode Operation
- Loop Back Self-Test Mode
- NRZ/NRZI Modes
- Quad Data Buffers for Each Rx and Tx
- Prioritized Status Register (Optional)
- MODEM/DMA/Loop Interface

MAXIMUM RATINGS

| Rating | Symbol | Value | Unit |
|--|------------------|--|------|
| Supply Voltage | Vcc | -0.3 to $+7.0$ | ٧ |
| Input Voltage | V _{in} | -0.3 to +70 | ٧ |
| Operating Temperature Range MC6854, MC68A54, MC68B54 MC6854C, MC68A54C | TA | (T _L to T _H) 0 to 70 – 40 to 85 | °C |
| Storage Temperature Range | T _{stg} | -65 to +150 | °C |

THERMAL CHRACTERISTICS

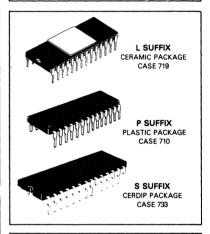
| THE INVINE OF THE PROPERTY | • | | |
|----------------------------|--------|-------|--------|
| Characteristic | Symbol | Value | Unit |
| Thermal Resistance | | | |
| Plastic | 1 , 1 | 115 | 1 0000 |
| Ceramic | θJA | 60 | °C/W |
| Cerdip | 1 1 | 65 | |

This device contains circuitry to protect the inputs against damage due to high static voltages or electric fields, however, it is advised that normal precautions be taken to avoid application of any voltage higher than maximum rated voltages to this high-impedance circuit. Reliability of operation is enhanced if unused inputs are tied to an appropriate logic voltage level (e.g., either VSS or VCC)

MOS

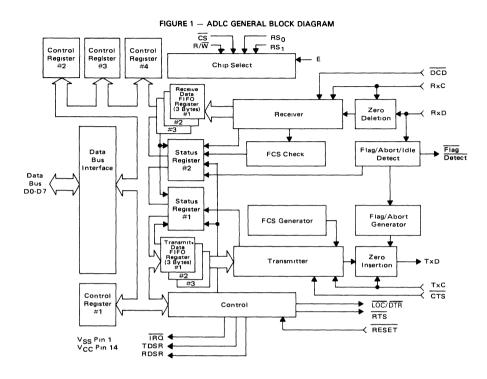
(N-CHANNEL, SILICON GATE)

ADVANCED DATA-LINK CONTROLLER



PIN DESCRIPTION

| ٧ss ت | 1 • U | 28 | <u>ICTS</u> |
|-------------------|-------|----|-------------|
| RTS | 2 | 27 | DCD |
| RxD [| 3 | 26 | LOC/DTR |
| RxC 🕻 | 4 | 25 | FLAG DET |
| TxC [| 5 | 24 | TDSR |
| TxD [| 6 | 23 | RDSR |
| IRQ [| 7 | 22 | D D0 |
| RESET | 8 | 21 | 1 D1 |
| <u> ट</u> ड € | 9 | 20 | D D2 |
| RSO [| 10 | 19 | DЗ |
| RS1 | 11 | 18 | 1 D4 |
| R/ ₩ [| 12 | 17 | 1 D5 |
| ΕC | 13 | 16 |] D6 |
| v _{CC} [| 14 | 15 | D 7 |



POWER CONSIDERATIONS

The average chip-junction temperature, TJ, in °C can be obtained from

$$T_{J} = T_{A} + (P_{D} \bullet \theta_{JA})$$
Where

T_A ≡ Ambient Temperature, °C

 $\theta_{JA} = Package Thermal Resistance, Junction-to-Ambient, °C/W$

PD≡PINT+PPORT

 $PINT = ICC \times VCC$, Watts - Chip Internal Power

PPORT = Port Power Dissipation, Watts - User Determined

For most applications PPORT ◀PINT and can be neglected PPORT may become significant if the device is configured to drive Darlington bases or sink LED loads

An approximate relationship between PD and TJ (if PPORT is neglected) is

$$P_D = K - (T_J + 273 ^{\circ}C)$$
 (2)
Solving equations 1 and 2 for K gives.

 $K = P_D \bullet (T_A + 273 \circ C) + \theta_{JA} \bullet P_D^2$ (3)

Where K is a constant pertaining to the particular part. K can be determined from equation 3 by measuring P_D (at equilibrium) for a known T_A . Using this value of K the values of P_D and T_J can be obtained by solving equations (1) and (2) iteratively for any value of T_A .

DC ELECTRICAL CHARACTERISTICS (V_{CC}=5 0 Vdc ±5%, V_{SS}=0, T_A=T_L to T_H unless otherwise noted)

| Characteristic | | Symbol | Min | Тур | Max | Unit |
|--|---------------------------|------------------|---------------------|-----|---------------------|------|
| Input High Voltage | • | VIH | V _{SS} +20 | _ | _ | ٧ |
| Input Low Voltage | | VIL | _ | - | Vss+08 | V |
| Input Leakage Current (V _{In} = 0 to 5 25 V) | All Inputs Except D0-D7 | lin | _ | 10 | 25 | μΑ |
| Three-State (Off-State) Input Current (V _{In} = 0 4 to 2 4 V, V _{CC} = 5 25 V) | D0-D7 | ΙΙΖ | _ | 2 0 | 10 | μΑ |
| DC Output High Voltage (I _{Load} = -205 μA) (V _{Load} = -100 μA) | D0-D7 All Others | Voн | VSS+24 VSS+24 | - | _ | ٧ |
| DC Output Low Voltage (I _{Load} = 1 6 mA) | | VOL | _ | _ | V _{SS} +04 | V |
| Output Leakage Current (Off State) (VOH = 2 4 V) | ĪRQ | loz | _ | 10 | 10 | μΑ |
| Internal Power Dissipation (measured at $T_A = T_L$) | | PINT | - | _ | 850 | mW |
| Capacitance $(V_{ID} = 0, T_A = 25$ °C, f = 1 0 MHz) | D0-D7 All Other Inputs | C _{in} | | - | 12 5 7 5 | pF |
| | IRQ All Others | C _{out} | _ | _ | 5 0 10 | pF |

AC ELECTRICAL CHARACTERISTICS ($V_{CC} = 5.0 \text{ V} \pm 5\%$, $V_{SS} = 0$, $T_A = T_L$ to T_H unless otherwise noted)

| | C | MC6854 | | MC68A54 | | MC68B54 | | Unit |
|--|---------------------------------|--------|------|---------|-----|---------|-----|------|
| Characteristic | Symbol | Min | Max | Min | Max | Min | Max | Onit |
| Clock Pulse Width, Low (RxC, TxC) | PWCL | 700 | _ | 450 | - | 280 | _ | ns |
| Clock Pulse Width, High (RxC, TxC) | PWCH | 700 | _ | 450 | _ | 280 | _ | ns |
| Serial Clock Frequency (RxC, TxC) | fsc | - | 0 66 | _ | 10 | _ | 15 | MHz |
| Receive Data Setup Time | tRDSU | 150 | _ | 100 | - | 50 | - | ns |
| Receive Data Hold Time | tRDH | 60 | _ | 60 | _ | 60 | - | ns |
| Request-to-Send Delay Time | tRTS | - | 680 | - | 460 | _ | 340 | ns |
| Clock-to-Data Delay for Transmitter | tTDD | - | 300 | _ | 250 | _ | 200 | ns |
| Flag Detect Delay Time | tFD | _ | 680 | - | 460 | _ | 340 | ns |
| DTR Delay Time | †DTR | - | 680 | - | 460 | - | 340 | nş |
| Loop On-Line Control Delay Time | †LOC | _ | 680 | | 460 | - | 340 | ns |
| RDSR Delay Time | tRDSR | - | 540 | - | 400 | - | 340 | ns |
| TDSR Delay Time | tTDSR | - | 540 | - | 400 | _ | 340 | ns |
| Interrupt Request Release Time | tIR | _ | 1 2 | 1 | 09 | _ | 07 | μS |
| RESET Pulse Width | tRESET | 10 | - | 0 65 | _ | 0 40 | _ | μS |
| Input Rise and Fall Times (Except Enable) (0 8 V to 2 0 V) | t _r , t _f | T - | 10* | - | 10* | - | 10* | μS |

^{*10} μs or 10% of the pulse width, whichever is smaller

FIGURE 2 - BUS TIMING TEST LOADS

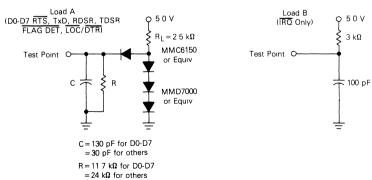


FIGURE 3 RECEIVER DATA SETUP/HOLD, FLAG DETECT AND LOOP ON-LINE CONTROL DELAY TIMING

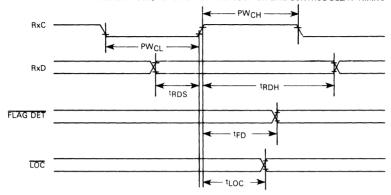


FIGURE 4 - TRANSMIT DATA OUTPUT DELAY AND REQUEST-TO-SEND DELAY TIMING

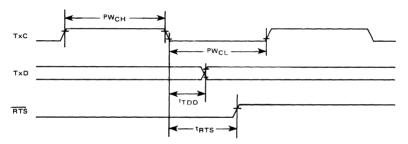
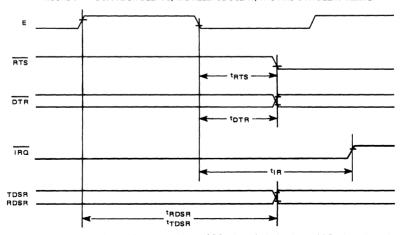


FIGURE 5 - TDSR/RDSR DELAYS, IRQ RELEASE DELAY, RTS AND DTR DELAY TIMING

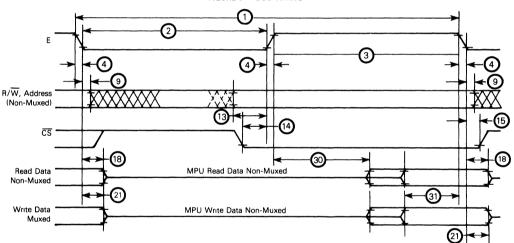


Note: Timing measurements are referenced to and from a low voltage of 0.8 volts and a high voltage of 2.0 volts, unless otherwise noted

BUS TIMING CHARACTERISTICS (See Notes 1 and 2)

| ldent. | Characteristics | Symbol | MC6854 | | MC68A54 | | MC68B54 | | Unit |
|--------|---------------------------------|---------------------------------|--------|------|---------|------|---------|------|--------|
| Number | Citatacteristics | Syllibol | Min | Max | Min | Max | Min | Max | OI III |
| 1 | Cycle Time | t _{cyc} | 1.0 | 10 | 0.67 | 10 | 0.5 | 10 | μS |
| 2 | Pulse Width, E Low | PWEL | 430 | 9500 | 280 | 9500 | 210 | 9500 | ns |
| 3 | Pulse Width, E High | PWEH | 450 | 9500 | 280 | 9500 | 220 | 9500 | ns |
| 4 | Clock Rise and Fall Time | t _r , t _f | _ | 25 | _ | 25 | _ | 20 | ns |
| 9 | Address Hold Time | tAH | 10 | - | 10 | - | 10 | | ns |
| 13 | Address Setup Time Before E | tAS | 80 | _ | 60 | - | 40 | - | ns |
| 14 | Chip Select Setup Time Before E | tcs | 80 | _ | 60 | - | 40 | - | ns |
| 15 | Chip Select Hold Time | tCH | 10 | _ | 10 | _ | 10 | - | ns |
| 18 | Read Data Hold Time | tDHR | 20 | 100 | 20 | 100 | 20 | 100 | ns |
| 21 | Write Data Hold Time | tDHW | 10 | _ | 10 | - | 10 | _ | ns |
| 30 | Output Data Delay Time | tDDR | - | 290 | - | 180 | - | 150 | ns |
| 31 | Input Data Setup Time | tDSW | 165 | _ | 80 | _ | 60 | - | ns |

FIGURE 6 - BUS TIMING



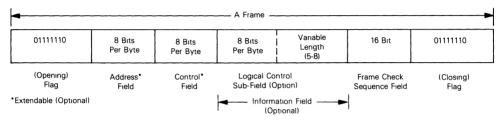
- 1 Voltage levels are V_L \leq 0 4 V, V_H \geq 2 4 V, unless othewise specified 2 Measurement points shown are 0 8 V and 2 0 V, unless otherwise specified

FRAME FORMAT

The ADLC transmits and receives data (information or control) in a format called a frame. All frames start with an opening flag (F) and end with a closing flag (F). Between the

opening flag and closing flag, a frame contains an address field, control field, information field (optional) and frame check sequence field

FIGURE 7 - DATA FORMAT OF A FRAME



Flag (F) — The flag is the unique binary pattern (01111110) It provides the frame boundary and a reference for the position of each field of the frame.

The ADLC transmitter generates a flag pattern internally and the opening flag and closing flags are appended to a frame automatically. Two successive frames can share one flag for a closing flag of the first frame and for the opening flag of the next frame, if the "FF"/"F" control bit in the control register is reset

The receiver searches for a flag on a bit-by-bit basis and recognizes a flag at any time. The receiver establishes the frame synchronization with every flag. The flags mark the frame boundary and reference for each field but they are not transferred to the Rx FIFO. The detection of a flag is indicated by the Flag Detect output and by a status bit in the status register.

Order of Bit Transmission — Address, control and information field bytes are transferred between the MPU and the ADLC in parallel by means of the data bus. The bit on D0 (data bus bit 0, pin 22) is serially transmitted first, and the first serially received bit is transferred to the MPU on D0. The FCS field is transmitted and received MSB first.

Address (A) Field — The 8 bits following the opening flag are the address (A) field The A-field can be extendable if the Auto-Address Extend Mode is selected in control register #3 In the Address Extend Mode, the first bit (bit 0) in every address octet becomes the extend control bit When the bit is "0", the ADLC assumes another address octet will follow, and when the bit is "1", the address extension is terminated A "null" address (all "0's") does not extend. In the receiver, the Address Present status bit distinguishes the address field from other fields. When an address byte is available to be read in the receive FIFO register, the Address Present status bit is set and causes an interrupt (if enabled). The Address Present bit is set for every address octet when the Address Extend Mode is used

Control (C) Field — The 8 bits following the address field is the control (link control) field. When the Extended Control Field bit in control register #3 is selected, the C-field is extended to 16 bits.

Information (I) Field — The I-field follows the C-field and precedes the FCS field The I-field contains "data" to be transferred but is not always necessarily contained in every frame. The word length of the I-field can be selected from 5 to 8 bits per byte by control bits in control register #4. The I-field will continue until it is terminated by the FCS and closing flag. The receiver has the capability to handle a "partial" last byte. The last information byte can be any word length between 1 and 8 bits. If the last byte in the I-field is less than the selected word length, the receiver will right justify the received bits, fill the remaining bits of the receiver shift register with zeros, and transfer a full byte to the Rx FIFO Regardless of selected byte length, the ADLC will transfer 8 bits of data to the data bus. Unused bits for word lengths of 5, 6, and 7 will be zeroed.

Logical Control (LC) Field — When the Logical Control Field Select bit, in control register #3, is selected the ADLC separates the I-field into two sub-fields. The first sub-field is the Logical Control field and the following sub-field is the "data" portion of the I-field. The logical control field is 8 bits and follows the C-field, which is extendable by octets, if it is selected. The last bit (bit 7) is the extend control bit, and if it is a "1", the LC-field is extended one octet.

NOTE

Hereafter the word "Information field" or "I-field" is used as the data portion of the information field, and excludes the logical control field This is done in order to keep the consistency of the meaning of "Information field" as specified in SDLC, HDLC, and ADCCP standards

Frame Check Sequence (FCS) Field - The 16 bits preceding the closing flag is the FCS field. The FCS is the "cyclic redundancy check character (CRCC)." The polynomial $x^{16} + x^{12} + x^{5} + 1$ is used both for the transmitter and receiver. Both the transmitter and receiver polynomial registers are initialized to all "1's" prior to calculation of the FCS. The transmitter calculates the FCS on all bits of the address, control, logical control (if selected), and information fields, and transmits the complement of the resulting remainder as FCS. The receiver performs the similar computation on all bits of the address, control, logical control (if selected), information, and received FCS fields and compares the result to F0B8 (Hexadecimal). When the result matches F0B8, the Frame Valid status bit is set in the status register. If the result does not match, the Error status bit is set. The FCS generation, transmission, and checking are performed automatically by the ADLC transmitter and receiver. The FCS field is not transferred to the Rx FIFO.

Invalid Frame — Any valid frames should have at least the A-field, C-field, and FCS field between the opening flag and the closing flag. When invalid frames are received, the ADLC handles them as follows:

- A short frame which has less than 25 bits between flags — the ADLC ignores the short frame and its reception is not reported to the MPU
- 2 A frame less than 32 bits between the flags, or a frame 32 bits or more with an extended A-field or C-field that is not completed. — This frame is transferred into the Rx FIFO. The FCS/IF Error status bit indicates the reception of the invalid frame at the end of the frame.
- Aborted Frame The frame which is aborted by receiving an abort or DCD failure is also an invalid frame. Refer to "Abort" and "DCD status bit".

Zero Insertion and Zero Deletion — The Zero insertion and deletion, which allows the content of the frame to be transparent, are performed by the ADLC automatically. A binary 0 is inserted by the transmitter after any succession of five "1's" within a frame (A, C, LC, I, and FCS field). The receiver deletes a binary 0 that follows successive five continuous "1's" within a frame.

Abort — The function of prematurely terminating a data link is called "abort." The transmitter aborts a frame by sending at least eight consecutive "1's" immediately after the Tx Abort control bit in control register #4 is set to a "1". (Tx FIFO is also cleared by the Tx Abort control bit at the same time.) The abort can be extended up to (at least) 16 consecutive "1's", if the Abort Extend control bit in the control register #4 is set when an abort is sent. This feature is useful to force mark idle transmission. Reception of seven or more consecutive "1's" is interpreted as an abort by the receiver. The receiver responds to a received abort as follows.

- An abort in an "out of frame" condition an abort during the idle or time fill has no meaning. The abort reception is indicated in the status register as long as the abort condition continues; but neither an interrupt nor a stored condition occurs. The abort indication disappears after 15 or more consecutive "1's" are received (Received Idle status is set.)
- 2. An abort "in frame" after less than 26 bits are received after an opening flag under this condition, any field

- of the aborted frame has not transferred to the MPU yet. The ADLC clears the aborted frame data in the FIFO and clears flag synchronization. Neither an interrupt nor a stored status occurs. The status indication is the same as (1) above.
- 3. An abort "in frame" after 26 bits or more are received after an opening flag — under this condition, some fields of the aborted frame might have been transferred onto the data bus. The abort status is stored in the receiver status register and the data of the aborted frame in the ADLC is cleared. The synchronization is also cleared.

Idle and Time Fill — When the transmitter is in an "out of frame" condition (the transmitter is not transmitting a frame), it is in an idle state. Either a series of contiguous flags (time fill) or a mark idle (consecutive "1's" on a bit-by-bit basis) is selected for the transmission in an idle state by the Flag/Mark Idle control bit. When the receiver receives 15 or more consecutive "1's", the Receive Idle status bit is set and causes an interrupt. The flags and mark idle are not transferred to the Rx FIFO.

OPERATION

INITIALIZATION

During a power-on sequence, the ADLC is reset via the RESET input and internally latched in a reset condition to prevent erroneous output transitions. The four control registers must be programmed prior to the release of the reset condition. The release of the reset condition is performed via software by writing a "0" into the Rx RS control bit (receiver) and/or Tx RS control bit (transmitter). The release of the reset condition must be done after the RESET input has gone high

At any time during operation, writing a "1" into the Rx RS control bit or Tx RS control bit causes the reset condition of the receiver or the transmitter.

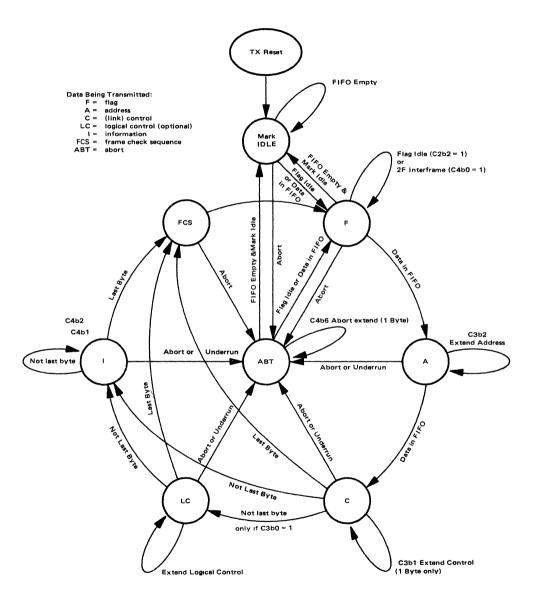
TRANSMITTER OPERATION

The Tx FIFO register cannot be pre-loaded when the transmitter is in a reset state. After the reset release, the Flag/Mark Idle control bit selects either the mark idle state inactive idle) or the Flag "time fill" (active idle) state. This active or inactive mark idle state will continue until data is loaded into the Tx FIFO.

The availability of the Tx FIFO is indicated by the TDRA status bit under the control of the 2-Byte/1-Byte control bit TDRA status is inhibited by the Tx RS bit or CTS input being high. When the 1-Byte mode is selected, one byte of the FIFO is available for data transfer when TDRA goes high When the 2-Byte mode is selected, two successive bytes can be transferred when TDRA goes high

The first byte (Address field) should be written into the Tx FIFO at the "Frame Continue" address. Then the transmission of a frame automatically starts. If the transmitter is in a mark idle state, the transfer of an address causes an opening flag within two or three transmitter clock cycles. If the transmitter has been in a time fill state, the current time fill flag being transmitted is assumed as an opening flag and the address field will follow it

FIGURE 8a — ADLC TRANSMITTER STATE DIAGRAM (Cjb; refers to control register bit)



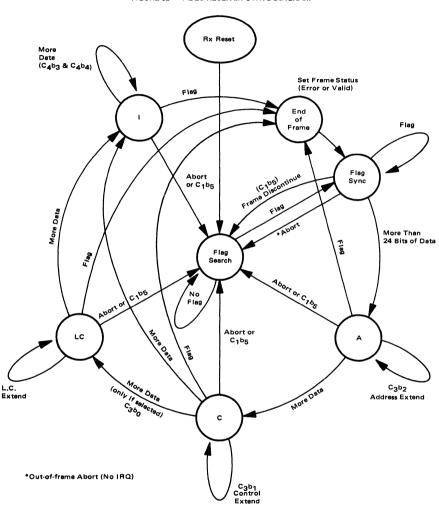


FIGURE 8b - ADLC RECEIVER STATE DIAGRAM

A frame continues as long as data is written into the Tx FIFO at the "Frame Continue" address. The ADLC internally keeps track of the field sequence in the frame. The frame format is described in the "FRAME FORMAT" section.

The frame is terminated by one of two methods. The most efficient way to terminate the frames from a software standpoint is to write the last data character into the Transmit FIFO "Frame Terminate" address (RS1, RS0=11) rather than the Transmit FIFO "Frame Continue" address (RS1, RS0=10). An alternate method is to follow the last write of data in the Tx FIFO "Frame Continue" address with the setting of the Transmit Last Data control bit. Either method

causes the last character to be transmitted and the FCS field to automatically be appended along with a closing flag. Data for a new frame can be loaded into the Tx FIFO immediately after the old frame data, if TDRA is high. The closing Flag can serve as the opening Flag of the next frame or separate opening and closing Flags may be transmitted. If a new frame is not ready to be transmitted, the ADLC will automatically transmit the Active (Flag) or Inactive (Mark) Idle condition.

If the Tx FIFO becomes empty at any time during frame transmission (the FIFO has no data to transfer into transmitter shift register during transmission of the last half of the

next to last bit of a word), an underrun will occur and the transmitter automatically terminates the frame by transmitting an abort. The underrun state is indicated by the Tx Underrun status bit.

Any time the Tx ABORT Control bit is set, the transmitter immediately aborts the frame (transmits at least 8 consecutive "1's") and clears the Tx FIFO If the Abort Extend Control bit is set at the time, an idle (at least 16 consecutive "1's") is transmitted. An abort or idle in an "out of frame" condition can be useful to gain 8 or 16 bits of delay. (For an example, see "Programming Considerations.")

The CTS (Clear-to-Send) input and RTS (Request-to-Send) output are provided for a MODEM or other hardware interface.

The TDRA/FC status bit (when selected to be Frame Complete Status) can cause an interrupt upon frame completion (i.e., a flag or abort completion).

Details regarding the inputs and outputs, status bits, control bits, and FIFO operation are described in their respective sections

RECEIVER OPERATION

Data and a pre-synchronized clock are provided to the ADLC receiver section by means of the Receive Data (RxD) and Receive Clock (RxC) inputs. The data is a continuous stream of binary bits with the characteristic that a maximum of five "1's" can occur in succession unless Abort, Flag, or Idling condition occurs. The receiver continuously (on a bit-by-bit basis) searches for Flags and Aborts.

When a flag is detected, the receiver establishes frame synchronization to the flag timing. If a series of flags is received, the receiver resynchronizes to each flag.

If the frame is terminated before the internal buffer time expires (the frame data is less than 25 bits after an opening flag), the frame is simply ignored. Noise on the data input (RxD) during time fill can cause this kind of invalid frame.

The received serial data enters a 32-bit shift register (clocked by RxC) before it is transferred into the Rx Data FIFO. Synchronization is established when a Flag is detected in the first eight locations of the shift register. Once synchronization has been achieved, data is clocked through to the last byte location of the shift register where it is transferred byteper-byte into the Rx Data FIFO. The Rx Data FIFO is clocked by E to cause received data to move through the FIFO to the last empty register location. The Receiver Data Available status bit (RDA) indicates when data is present in the last register (Register #3) for the 1-Byte Transfer Mode. The 2-Byte Transfer Mode causes the RDA status bit to indicate data is available when the last two FIFO register locations (Registers #2 and #3) are full. If the data character present in the FIFO is an address octet, the status register will exhibit an Address Present status condition. Data being available in the Rx Data FIFO causes an interrupt to be initiated (assuming the receiver interrupt is enabled, RIE="1"). The MPU will read the ADLC Status Register as a result of the interrupt or in its turn in a polling sequence. RDA or Address Present will indicate that receiver data is available and the MPU should subsequently read the Rx Data FIFO register. The interrupt and status bit will then be reset automatically. If more than one character had been received and was resident in the Rx Data FIFO, subsequent E clocks will cause the FIFO to update and the RDA status bit and interrupt will again be SET. In the 2-Byte Transfer Mode both data bytes may be read on consecutive E cycles. Address Present provides for 1 byte transfers only.

The sequence of each field in the received frame is automatically handled by the ADLC. The frame format is described in the "FRAME FORMAT" section.

When a closing flag is received, the frame is terminated. The 16 bits preceding the closing flag are regarded as the FCS and are not transferred to the MPU. Whatever data is present in the most-significant byte portion of the receiver buffer register it is right justified and transferred to the Rx FIFO. The frame boundary pointer, which is explained in the Rx FIFO. The frame boundary pointer sets the Frame Valid status bit (when the frame was completed with no error) or the FCS/IF Error Status bit (when the frame was completed with error) when the last byte of the frame appears at the last location of the Rx FIFO. As long as the Frame Valid or FCS/IF Error status bit is set, the data transfer from the second location of the Rx FIFO to the last location of the Rx FIFO is inhibited.

Any time the Frame Discontinue control bit is set, the ADLC discards the current frame data in the ADLC without dropping flag synchronization. This feature can be used to ignore a frame which is addressed to another station.

The reception of an abort or idle is explained in the "FRAME FORMAT" section. The details regarding the inputs, outputs, status bits, control bits, and Rx FIFO operation are described in their respective sections.

LOOP MODE OPERATION

The ADLC in the loop mode, not only performs the transmission and receiving of data frames in the manner previously described, but also has additional features for gaining and relinquishing loop control. In Figure 9a, a configuration is shown which depicts loop mode operation. The system configuration shows a primary station and several secondary stations. The loop is always under control of the primary station. When the primary wants to receive data, it transmits a Poll sequence and allows frame transmission to secondary stations on the loop. Each secondary is in series and adds one bit of delay to the loop. Secondary A in the figure receives data from the primary via its Rx Data Input, delays the data 1 bit, and transmits it to secondary B via its Tx Data Output. Secondaries B, C, and D operate in a similar manner. Therefore, data passes through each secondary and is received back by the primary controller.

Certain protocol rules must be followed in the manner by which the secondary station places itself on-loop (connects its transmitter output to the loop), goes active on the loop (starts transmitting its own station's data on the loop), and goes off the loop (disconnects its transmitter output). Otherwise loop data to other stations down loop would be interfered. The data stream always flows the same way and the order in which secondary terminals are serviced is determined by the hardware configuration. The primary controller times the delay through the loop. Should it exceed n + 1 bit times, where n is the number of secondary terminals on the loop, it will indicate a loop failure. Control is transferred to a secondary by transmitting a "Go Ahead" signal following the closing Flag of a polling frame (request for a response from the secondary) from the primary station. The "Go Ahead" from the primary is a "0" and seven "1's" followed by mark

FIGURE 9a - TYPICAL LOOP CONFIGURATION

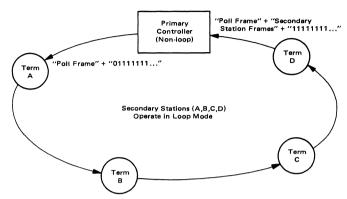
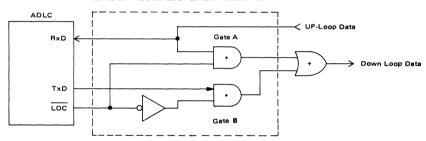


FIGURE 9b - EXAMPLE OF EXTERNAL LOOP LOGIC



Idling. The primary can abort its response request by interrupting its idle with flags. The secondary should immediately stop transmission and return control back to the primary. When the secondary completes its frame, a closing flag is transmitted followed by all "1's". The primary detects the final 01111111.. ("Go Ahead" to the primary) and control is given back to the primary. Note that, if a down-loop secondary (e.g., station D) needs to insert information following an up-loop station (e.g., station A), the go ahead to station D is the last "0" of the closing flag from station A followed by "1's".

The ADLC in the primary station should operate in a non-loop full-duplex mode. The ADLC in the secondaries should operate in a loop mode, monitoring up-loop data on its receiver data input. The ADLC can recognize the necessary sequences in the data stream to automatically go on/off the loop and to insert its own station data. The procedure is the following and is summarized in Table 1.

(1) Go On-Loop — When the ADLC powers up, the terminal station will be off line. The first task is to become an active terminal on the loop. The ADLC must be connected to a Loop Link via an external switch as shown in Figure 9a. After a hardware reset, the ADLC $\overline{LOC}/\overline{DTR}$ Output will be in the high state and the up-loop receive data repeated

through gate A to the down Loop stations. Any Up-Loop transmission will be received by the ADLC The Loop Mode/Non-Loop Mode Control bit (bit 5 in Control Register 3) must be set to place the ADLC in the Loop Mode. The ADLC now monitors its Rx Data input for a string of seven consecutive "1's" which will allow a station to go on line. The Loop operation may be monitored by use of the Loop Status bit in Status Register 1 After power up and reset, this bit is a zero. When seven consecutive "1's" are received by the ADLC the LOC/DTR output will go to a low level, disabling gate A (refer to Figure 9b), enabling gate B and connecting the ADLC Tx Data output to the down Loop stations. The up Loop data is now repeated to the down Loop stations via the ADLC. A 1-bit delay is inserted in the data (in NRZI mode, there will be a 2-bit delay) as it circulates through the ADLC. The ADLC is now on-line and the Loop Status bit in Status Register 1 will be at a one.

(2) Go Active after Poll — The receiver section will monitor the up-link data for a general or addressed poll command and the Tx FIFO should be loaded with data so that when the go ahead sequence of a zero followed by seven "1's" (011111111--) is detected, transmission can be initiated immediately. When the polling frame is detected, the Go-Active-On-Poll control bit must be set (bit 6 in Control

TABLE 1 - SUMMARY OF LOOP MODE OPERATION

| STATE | RX SECTION | TX SECTION | LOOP STATUS BIT |
|----------|---|---|--------------------|
| OFF-LOOP | Rx section receives data from loop and searches for 7 "1's" (when On-Loop Control bit set) to go ON-LOOP | Inactive 1) NRZ MODE Tx data output is maintained "high" (mark). 2) NRZI MODE. Tx data output reflects the Rx data input state delayed by one bit time (Not normally connected to loop.) The NRZI data is internally decoded to provide error-free transitions to On-Loop mode. | "0" |
| ON-LOOP | 1) When Go-Active on poll bit is set, Rx section searches for 01111111 pattern (the EOP or 'Go Ahead') to become the active terminal on the loop 2) When On-Loop control bit is reset, Rx section searches for 8 "1's" to go OFF-Loop | Inactive 1) NRZ MODE Tx data output reflects Rx data input state delayed one bit time. 2) NRZI MODE. Tx data output reflects Rx data input state delayed 2 bit times | "1" |
| ACTIVE | Rx section searches for flag (an interrupt from the loop controller) at Rx data input Received flag causes FD output to go low IRO is generated if RIE and FDSE control bits are set | Tx data originates within ADLC until Go Active on Poll bit is reset and a flag or Abort is completed Then returns to ON-Loop state | "0" |

Register 3) A maximum of seven bit times are available to set this control bit after the closing flag of the poll. When the Go-Ahead is detected by the receiver, the ADLC will automatically change the seventh one to a zero so that the repeated sequence out gate B in Figure 9b is now an opening flag sequence (011111110). Transmission now continues from the Tx FIFO with data (address, control, etc.) as previously described. When the ADLC has gone active-onpoll, the Loop Status bit in Status Register 1 will go to a zero. The receiver searches for a flag, which indicates that the primary station is interrupting the current operation.

(3) Go Inactive when On-Loop — The Go-Active-On-Poll control bit may be RESET at any time during transmission When the frame is complete (the closing Flag or abort is transmitted), the Loop is automatically released and the station reverts back to being just a 1-bit delay in the Loop, repeating up-link data. If the Go-Active-On-Poll control bit is not reset by software and the final frame is transmitted (Flag/Mark Idle bit = 0), then the transmitter will mark idle and will not release the loop to up-loop data. A Tx Abort command would have to be used in this case in order to go inactive when on the loop. Also, if the Tx FIFO was not preloaded with data (address, control, etc.) prior to changing the "Go Ahead Character" to a Flag, the ADLC will either transmit flags (active idle character) until data is loaded (when Flag/Mark Idle Control bit is high) or will go into an underrun condition and transmit an Abort (when Flag/Mark Idle control bit is low) When an abort is transmitted, the Go-Active-on-Poll control bit is reset automatically and the ADLC reverts to its repeating mode, (TxD = delayed RxD) When the ADLC transmitter lets go of the loop, the Loop Status bit will return to a "1", indicating normal on-loop retransmission of up-loop data

(4) Go Off-Loop — The ADLC can drop off the Loop (go off-line) similar to the way it went on-line. When the Loop On-Line control bit is reset the ADLC receiver section looks for eight successive "1's" before allowing the $\overline{\text{LOC}/\text{DTR}}$ output to return high (the inactive state). Gate A in Figure 9b will be enabled and gate B disabled allowing the loop to maintain continuity without disturbance. The Loop Status bit will show an off-line condition (logical zero)

SIGNAL DESCRIPTIONS

All inputs of ADLC are high-impedance and TTL-compatible level inputs. All outputs of the ADLC are compatible with standard TTL. Interrupt Request (\overline{IRQ}) , however, is an open-drain output (no internal pullup)

INTERFACE FOR MPU

Bidirectional Data Bus (D0-D7) — These data bus I/O ports allow the data transfer between ADLC and system bus The data bus drivers are three-state devices that remain in the high-impedance (off) state except when the MPU performs an ADLC read operation

Enable Clock (E) - E activates the address inputs ($\overline{\text{CS}},$ RSO, and RS1) and R/W input and enables the data transfer on the data bus E also moves data through the Tx FIFO and Rx FIFO E should be a free-running clock such as the MC6800 MPU system clock

Chip Select (\overline{CS}) — An ADLC read or write operation is enabled only when the \overline{CS} input is low and the E clock input is high $(E \bullet \overline{CS})$

Register Selects (RS0, RS1) — When the Register Select inputs are enabled by $(E \cdot \overline{CS})$, they select internal registers in conjunction with the Read/Write input and Address Control bit (control register 1, bit 0). Register addressing is defined in Table 2

Read/Write Control Line (R/W) — The R/W input controls the direction of data flow on the data bus when it is enabled by (E \bullet CS). When R/W is high, the I/O Buffer acts as an output driver and as an input buffer when low. It also selects the Read Only and Write Only registers within the ADI C

Reset Input (RESET) — The RESET input provides a means of resetting the ADLC from a hardware source. In the "low state," the RESET input causes the following:

- *Rx Reset and Tx Reset are SET causing both the Receiver and Transmitter sections to be held in a reset condition.
- *Resets the following control bits: Transmit Abort, RTS, Loop Mode, and Loop On-Line/DTR.
- *Clears all stored status condition of the status registers.
 *Outputs: RTS and LOC/DTR go high TxD goes to the mark state ("1's" are transmitted).

When RESET returns "high" (the inactive state) the transmitter and receiver sections will remain in the reset state until Tx Reset and Rx Reset are cleared via the data bus under software control. The Control Register bits affected by RESET cannot be changed when RESET is "low."

Interrupt Request Output (\overline{IRQ}) — \overline{IRQ} will be low if an interrupt situation exists and the appropriate interrupt enable has been set. The interrupt remains as long as the cause for the interrupt is present and the enable is set. \overline{IRQ} will be low as long as the \overline{IRQ} status bit is set and is high if the \overline{IRQ} status bit is not set.

CLOCK AND DATA OF TRANSMITTER AND RECEIVER

Transmitter Clock Input (TxC) — The transmitter shifts data on the negative transition of the TxC clock input. When the Loop Mode or Test Mode is selected, TxC should be the same frequency and phase as the RxC clock. The data rate of the transmitter should not exceed the E frequency.

Receiver Clock Input (RxC) — The receiver samples the data on the positive transition of the RxC clock RxC should be synchronized with receive data externally.

Transmit Data Output (TxD) — The serial data from the transmitter is coded in NRZ or NRZI (Zero Complement) data format.

Receiver Data Input (RxD) — The serial data to be received by the ADLC can be coded in NRZ or NRZI (Zero Complement) data format. The data rate of the receiver should not exceed the E frequency. If a partial byte reception is possible at the end of a frame, the maximum data rate of the receiver is indicated by the following relationship:

$$f_{RxC} \le \frac{1}{2t_E + 300 \text{ ns}}$$

where te is the period of E.

PERIPHERAL/MODEM CONTROL

Request-to-Send Output (\overline{RTS}) — The Request-to-Send output is controlled by the Request-to-Send control bit in conjunction with the state of the transmitter section. When the \overline{RTS} bit goes high, the \overline{RTS} output is forced low. When the \overline{RTS} bit returns low, the \overline{RTS} output remains low until the end of the frame and there is no further data in the Tx FIFO for a new frame. The positive transition of \overline{RTS} occurs after the completion of a Flag, an Abort, or when the RTS control bit is reset during a mark idling state. When the \overline{RTS} input is low, the \overline{RTS} output goes high.

Clear-to-Send Input ($\overline{\text{CTS}}$) — The $\overline{\text{CTS}}$ input provides a real-time inhibit to the TDRA status bit and its associated interrupt. The positive transition of $\overline{\text{CTS}}$ is stored within the ADLC to ensure its occurrence will be acknowledged by the system. The stored $\overline{\text{CTS}}$ information and its associated $\overline{\text{IRO}}$ (if enabled) are cleared by writing a "1" in the Clear Tx Status bit or in the Transmitter Reset bit.

Data-Carrier-Detect Inupt ($\overline{\text{DCD}}$) — The $\overline{\text{DCD}}$ input provides a real-time inhibit to the receiver section. A high level on the $\overline{\text{DCD}}$ input resets and inhibits the receiver register, but data in the Rx FIFO from a previous frame is not disturbed. The positive transition of $\overline{\text{DCD}}$ is stored within the ADLC to ensure that its occurrence will be acknowledged by the system. The stored $\overline{\text{DCD}}$ information and its associated $\overline{\text{IRQ}}$ (if enabled) are cleared by means of the Clear Rx Status Control bit or by the Rx Reset bit.

Flag Detect Output ($\overline{\text{FD}}$) — An output to indicate the reception of a flag and initiate an external time-out counter for the loop mode operation. The $\overline{\text{FD}}$ output goes low for 1 bit time beginning at the last bit of the flag character, as sampled by the receiver clock (RxC).

DMA INTERFACE

Receiver Data Service Request Output (RDSR) — The RDSR Output is provided primarily for use in DMA Mode operation and indicates (when high) that the Rx FIFO requests service (RSDR output reflects the RDA status bit regardless of the state of the RDSR mode control bit in CR1). If the prioritized Status Mode is selected, RDSR will be inhibited when any other receiver status conditions are present. RDSR goes low when the Rx FIFO is read

Transmitter Data Service Request Output (TDSR) — The TDSR Output is provided for DMA mode operation and indicates (when high) that the Tx FIFO request service regardless of the state of the TDSR Mode Control bit in CR1 TDSR goes low when the Tx FIFO is loaded. TDSR is inhibited by: the Tx RS control bit being SET, RESET being low, or CTS being high. If the prioritized status mode is used, Tx Underrun also inhibits TDSR. TDSR reflects the TDRA status bit except in the FC mode. In the FC mode the TDSR line is inhibited.

ADLC REGISTERS

Eight registers in the ADLC can be accessed by means of the MPU data and address buses. The registers are defined as read-only or write-only according to the direction of information flow. The addresses of these registers are defined in Table 2. The transitter FIFO register can be accessed by two different addresses, the "Frame Terminate" address and the "Frame Continue" address. (The function of these addresses are discussed in the FIFO section.)

TABLE 2 - REGISTER ADDRESSING

| Register Selected | R/W | RS1 | RS0 | Address Control Bit (C ₁ b ₀) |
|---------------------------|-----|-----|-----|--|
| Write Control Register #1 | 0 | 0 | 0 | х |
| Write Control Register #2 | 0 | 0 | 1 | 0 |
| Write Control Register #3 | 0 | 0 | 1 | 1 |
| Write Transmit FIFO | 0 | 1 | 0 | × |
| (Frame Continue) | | | | |
| Write Transmit FIFO | 0 | 1 | 1 | 0 |
| (Frame Terminate) | | | | |
| Write Control Register #4 | 0 | 1 | 1 | 1 |
| Read Status Register #1 | 1 | 0 | 0 | × |
| Read Status Register #2 | 1 | 0 | 1 | × |
| Read Receiver FIFO | 1 | 1 | Х | Х |

RECEIVER DATA FIRST-IN FIRST-OUT REGISTER

Rx FIFO — The Rx FIFO consists of three 8-bit registers which are used for the buffer storage of received data. Data bytes are always transferred from a full register to an adjacent empty register; and both phases of the E input clock are

used for the data transfer. Each register has pointer bits which point the frame boundary. When these pointers appear at the last FIFO location, they update the Address Present, Frame Valid, or FCS/IF Error status bits.

The RDA status bit indicates the state of the Rx FIFO. When RDA status bit is "1", the Rx FIFO is ready to be read. The RDA status is controlled by the 2-Byte/1-Byte control bit. When overrun occurs, the data in the first byte of the Rx FIFO are not longer valid.

Both the Rx Reset bit and $\overline{\text{RESET}}$ input clear the Rx FIFO. Abort ("in Frame") and a high level on the $\overline{\text{DCD}}$ input also clears the Rx FIFO, but the last bytes of the previous frame, which are separated by the frame boundary pointer, are not disturbed

TRANSMITTER DATA FIRST-IN FIRST-OUT REGISTER

Tx FIFO - The Tx FIFO consists of three 8-bit registers which are used for buffer storage of data to be transmitted. Data is always transferred from a full register to an empty adjacent register; the transfer occurs on both phases of the E input clock. The Tx FIFO can be addressed by two different register addresses, the "Frame Continue" address and the "Frame Terminate" address. Each register has pointer bits which point to the frame boundary. When a data byte is written at the "Frame Continue" address, the pointer of the first FIFO register is set. When a data byte is written at the "Frame Terminate" address, the pointer of the first FIFO register is reset. Rx RS control bit or Tx Abort control bit resets all pointers. The pointer will shift through the FIFO. When a positive transition is detected at the third location of FIFO, the transmitter initiates a frame with an open flag. When the negative transition is detected at the third location of FIFO, the transmitter closes a frame, appending the FCS and closing Flag to the last byte.

The Tx last control bit can be used instead of using the "Frame Terminate" address. When the Tx last control bit is set with a "1", the logic searches the last byte location in the FIFO and resets the pointer in the FIFO register.

ADLC INTERNAL REGISTER STRUCTURE

| | | RS1 RS0 = 00 | RS1 RS0 = 01 | RS1 RS0 = 10 | RS1 RS0 = 11 |
|-----------|-------|------------------------------|-------------------------------|---------------------------|-----------------------|
| | Bit # | Status Register #1 | Status Register #2 | Receiver Data Register | |
| | 0 | RDA | Address Present | Bit 0 | |
| Registers | 1 | Status #2 Read Request | Frame Valid | Bit 1 | |
| ě | 2 | Loop | Inactive Idle Received | Bit 2 | |
| Only | 3 | Flag Detected (When Enabled) | Abort Received | Bit 3 | Same as RS1, RS0 = 10 |
| Read | 4 | CTS | FCS Error | Bit 4 | |
| Œ | 5 | Tx Underrun | DCD | Bit 5 | |
| | 6 | TDRA/Frame Complete | Rx Overrun | Bit 6 | |
| | 7 | IRQ Present | RDA (Receiver Data Available) | Bit 7 | |

| | | | | | Transmitter Data | Transmitter Data | |
|----------------------|-------|---------------------------------------|--|--|---------------------|--|--|
| | Bıt # | Control Register #1 | Control Register #2 (C ₁ b ₀ = 0) | Control Register #3 (C ₁ b ₀ = 1) | (Continue Data) | (Last Data) (C ₁ b ₀ = 0) | Control Register #4 (C ₁ b ₀ = 1) |
| ٤ | 0 | Address Control (AC) | Prioritized Status Enable | Logical Control Field Select | Bit 0 | Bit 0 | Double Flag/Single Flag Interframe Control |
| legiste | 1 | Receiver Interrupt Enable (RIE) | 2 Byte/1 Byte Transfer | Extended Control Field Select | Bit 1 | Bit 1 | Word Length Select Transmit #1 |
| Write Only Registers | 2 | Transmitter Interrupt Enable (TIE) | Flag/Mark Idle | Auto, Address Extension Mode | Bit 2 | Bit 2 | Word Length Select Transmit #2 |
| | 3 | RDSR Mode (DMA) | Frame Complete/ TDRA Select | 01/11 Idle | Bit 3 | Bit 3 | Word Length Select Receive #1 |
| | 4 | TDSR Mode (DMA) | Transmit Last Data | Flag Detected Status Enable | Bit 4 | Bit 4 | Word Length Select Receive #2 |
| | 5 | Rx Frame Discontinue | CLR Rx Status | Loop/Non-Loop Mode | Bit 5 | Bit 5 | Transmit Abort |
| | 6 | Rx RESET | CLR Tx Status | Go Active on Poll/Test | Bit 6 | Bit 6 | Abort Extend |
| | 7 | Tx RESET | RTS Control | Loop On-Line Control DTR | Bit 7 | Bit 7 | NRZI/NRZ |

CONTROL REGISTERS

| 7 6 5 4 3 2 1 RS1 RS0 R/W AC TxRS RxRS Discontinue TDSR RDSR TIE RIE 0 0 0 0 0 X | | | | | | | | R1) | R 1 (C | GISTE | ROL RI | CONT |
|--|----|-----|-----|------|------|-------------|------|------|--------|------------------|--------|------|
| | 0 | 1 | 2 | 3 | 4 | 5 | 6 | 7 | | | | |
| 0 0 0 X | AC | RIE | TIE | RDSR | TDSR | Discontinue | RxRS | TxRS | AC | R/\overline{W} | RS0 | RS1 |
| 0 0 0 X | ĺ | | | Mode | Mode | | | | × | 0 | 0 | 0 |

- **b0** Address Control (AC) AC provides another RS (Register Select) signal internally. The AC bit is used in conjunction with RSO, RS1, and R/W inputs to select particular registers, as shown in Table 2.
- b1 Receiver Interrupt Enable (RIE) RIE enables/disables the interrupt request caused by the receiver section 1 enable, 0 disable
- **b2** Transmitter Interrupt Eanble (TIE) TIE enables/disables the interrupt request caused by the transmitter 1 enable, 0 disable
- $\mbox{b3}$ Receiver Data Service Request Mode (RDSR MODE) The RDSR MODE bit provides the capability of operation with a bus system in the DMA mode when used in conjunction with the prioritized status mode. When RDSR MODE is set, an interrupt request caused by RDA status is inhibited, and the ADLC does not request data transfer via the $\overline{\mbox{IRO}}$ output
- **b4** Transmitter Data Service Request Mode (TDSR MODE) The TDSR MODE bit provides the capability of operation with a bus system in the DMA mode when used in conjunction with the prioritized status mode When TDSR MODE is set, an interrupt request caused by TDRA status is inhibited, and the ADLC does not request a data transfer via the IRO output

- b5 Rx Frame Discontinue (DISCONTINUE) When the DISCONTINUE bit is set, the currently received frame is ignored and the ADLC discards the data of the current frame The DISCONTINUE bit only discontinues the current by received frame and has no affect on subsequent frames, even if a following frame has entered the receiver section The DISCONTINUE bit is automatically reset when the last byte of the frame is discarded. When the ignored frame is aborted by receiving an Abort or DCD failure, the DISCONTINUE bit is also reset.
- **b6** Receiver Reset (Rx RS) When the Rx RS bit is "1", the receiver section stays in the reset condition. All receiver sections, including the Rx FIFO register and the receiver status bits in both status registers, are reset (During reset, the stored DCD status is reset but the DCD status bit follows the DCD input.) Rx RS is set by forcing a low level on the RESET input or by writing a "1" into the bit from the data bus. Rx RS must be reset by writing a "0" from the data bus after RESET has gone high.
- **b7 Transmitter Reset (Tx RS)** When the Tx RS bit is "1", the transmitter section stays in the reset condition and transmits marks ("1's"). All transmitter sections, including the Tx FIFO and the transmitter status bits, are reset (FIFO cannot be loaded) During reset, the stored CTS status is reset but the CTS status bit follows the $\overline{\text{CTS}}$ input Tx RS is set by forcing a low level on the $\overline{\text{RESET}}$ input or by writing a "1" from the data bus. It must be reset by writing a "0" after $\overline{\text{RESET}}$ has gone high

| 7 6 5 4 3 2 1 0 RS1 RS0 R/W AC RTS CLR CLR Tx FC/TDRA F/M 2/1 PSE CLR TxST RxST Last Select Idle Byte CLR CLR CLR CLR Tx FC/TDRA F/M 2/1 PSE CLR | CONT | ROL RI | GISTE | R 2 (C | R2) | | | | | | | |
|--|------|----------|-------|--------|-----|-----|---|---|---|---|---|-----|
| | | | | | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| | | RSO 1 | | | RTS | , i | _ | 1 | | | | PSE |

- **b0 Prioritized Status Enable (PSE)** When the PSE bit is SET, the status bits in both status registers are prioritized as defined in the Status Register section. When PSE is low, the status bits indicate current status without bit suppression by other status bits. The exception to this rule is the $\overline{\text{CTS}}$ status bit which always supresses the TDRA status.
- **b1 2-Byte/1-Byte Transfer (2/1 Byte)** When the 2/1 Byte bit is RESET the TDRA and RDA status bits then will indicate the availability of their respective data FIFO registers for a single-byte data transfer. Similarly, if 2/1 Byte is set, the TDRA and RDA status bit indicate when two bytes of data can be moved without a second status read.
- **b2** Flag/Mark Idle Select (F/M Idle) The F/M Idle bit selects Flag characters or bit-by-bit Mark Idle for the time fill or the idle state of the transmitter. When Mark Idle is selected, Go-Ahead code can be generated for loop operation in conjunction with the 01/11 Idle control bit (C3b3). 1...Flag time fill, 0...Mark Idle.
- b3 Frame Complete/TDRA Select (FC/TDRA Select) The FC/TDRA Select bit selects TDRA status or FC status for the TDRA/FC status bit indication 1 . FC status, 0.. TDRA status.
- **b4 Transmit Last Data (Tx Last)** Tx Last bit provides another method to terminate a frame. This bit should be set

- after loading the last data byte and before the Tx FIFO empties. When the Tx Last bit is set, the ADLC assumes the byte is the last byte and terminates the frame by appending CRCC and a closing Flag. This control bit is useful for DMA operation. Tx Last bit automatically returns to the "0" state.
- **b5** Clear Receiver Status (CLR Rx ST) When a "1" is written into the CLR Rx ST bit, a reset signal is generated for the receiver status bits in status registers #1 and #2 (except AP and RDA bits). The reset signal is enabled only for the bits which have been present during the last "read status" operation. The CLR Rx ST bit automatically returns to the "0" state.
- **b6** Clear Transmitter Status (CLR Tx ST) When a "1" is written into CLR Tx ST bit, a reset signal is generated for the transmitter status bits in status register #1 (except TDRA). The reset signal is enabled for the bits which have been present during the last "read status" operation. The CLR Tx ST bit automatically returns to the "0" state.
- **b7** Request-to-Send Control (RTS) The RTS bit, when high, causes the $\overline{\text{RTS}}$ output to be low (the active state). When the $\overline{\text{RTS}}$ bit returns low and data is being transmitted, the $\overline{\text{RTS}}$ output remains low until the last character of the frame (the closing Flag or Abort) has been completed and the Tx FIFO is empty. If the transmitter is idling when the RTS bit returns low, the $\overline{\text{RTS}}$ output will go high (the inactive state) within two bit times

| CONTROL REGISTER 3 (CR3) | | | | | | | | | | | |
|--------------------------|-----|------------------|----|------|------|------|------|-------|-----|-----|-----|
| | | | | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| RS1 | RS0 | R/\overline{W} | AC | LOC/ | GAP/ | Loop | FDSE | 01/11 | AEX | CEX | LCF |
| 0 | 1 | 0 | 1 | DTR | TST | | | Idle | | | |
| | | | | | | | | | | | |

b0 — **Logical Control Field Select (LCF)** — The LCF select bit causes the first byte(s) of data belonging to the information field to remain 8-bit characters until the logical control field is complete. The logical control field (when selected) is an automatically extendable field which is extended when bit 7 of a logical control character is a "1." When the LCF Select bit is reset the ADLC assumes no logical control field is present for either the transmit or received data channels. When the logical control field is terminated, the word length of the information data is then defined by WLS₁ and WLS₂

b1 — Extended Control Field Select (CEX) — When the CEX bit is a "1", the control field is extended and assumed to be 16 bits. When CEX is "0", the control field is assumed to be 8 bits.

b2 — Auto/Address Extend Mode (A_{EX}) — The A_{EX} bit when "low" allows full 8 bits of the address octet to be utilized for addressing because address extension is inhibited. When the A_{EX} bit is "high," bit 0 of address octet equal to "0" causes the Address field to be extended by one octet. The exception to this automatic address field extension is when the first address octet is all "0's" (the Null Address).

b3 — 01/11 Idle (01/11 Idle) — The 01/11 Idle Control bit determines whether the inactive (Mark) idle condition begins with a "0" or not. If the 01/11 Idle Control is SET, the closing flag (or Abort) will be followed by a 011111...pattern. This is required of the controller for the "Go Ahead" character in the Loop Mode. When 01/11 is RESET, the idling condition will be all "1"s"

b4 — Flag Detect Status Enable (FDSE) — The FDSE bit enables the FD status bit in Status Register #1 to indicate the occurrence of a received Flag character. The status indication will be accompanied by an interrupt if RIE is SET Flag

detection will cause the Flag Detect output to go low for 1 bit time regardless of the state of FDSE.

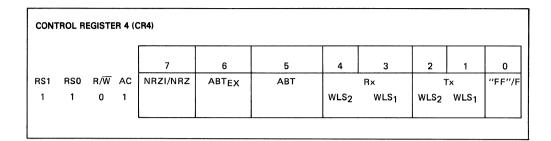
b5 — LOOP/NON-LOOP Mode (LOOP) — When the LOOP bit is set, loop mode operation is selected and the GAP/TST control bit, LOC/DTR control bit and LOC/DTR output are selected to perform the loop control functions. When LOOP is reset, the ADLC operates in the point-to-point data communications mode.

b6 — **Go Active On Poll/Test (GAP/TST)** — *In the Loop Mode* — The GAP/TST bit is used to respond to the poll sequence and to begin transmission. When GAP/TST is set, the receiver searches for the "Go Ahead" (or End of Poll, EOP). The receiver "Go ahead" is converted to an opening Flag and the ADLC starts its own transmission. When GAP/TST is reset during the transmission, the end of the frame (the completion of Flag or Abort) causes the termination of the "go-active-on-poll" operation and the Rx Data to Tx Data link is re-established. The ADLC then returns to the "loop-on-line" state.

In the Non-Loop Mode — The GAP/TST bit is used for self-test purposes. If GAP/TST bit is set, the TxD output is connected to the RxD input internally, and provides a "loop-back" feature. For normal operation, the GAP/TST bit should be reset.

b7 — Loop On-Line Control/DTR Control (LOC/DTR) — In the Loop Mode — The LOC/DTR bit is used to go on-line or to go off-line. When LOC/DTR is set, the ADLC goes to the on-line state after 7 consecutive "1's" occur at the RxD input. When LOC/DTR is reset, the ADLC goes to the "off-line" state after eight consecutive "1's" occur at the RxD input.

In the Non-Loop Mode — The LOC/DTR bit directly controls the Loop On-Line/ $\overline{\text{DTR}}$ output state 1... $\overline{\text{DTR}}$ output goes to low level, 0... $\overline{\text{DTR}}$ output goes to high level.



b0 — Double Flag/Single Flag Interframe Control ("FF"/"F") — The "FF"/"F" Control bit determines whether the transmitter will transmit separate closing and opening Flags when frames are transmitted successively. When the "FF"/"F" control bit is low, the closing flag of the first frame will serve as the opening flag of the second frame When the bit is high, independent opening and closing flags will be transmitted.

b1, b2 — Transmitter Word Length Select (Tx WLS1 and WLS2) — Tx WLS1 and WLS2 are used to select the word length of the transmitter information field. The encoding format is shown in Table 3.

b3, b4 — Receiver Word Length Select (Rx WLS1 and WLS2) — Rx WLS1 and WLS2 are used to select the word length of the receiver information field. The encoding format is shown in Table 3.

TABLE 3 - I-FIELD CHARACTER LENGTH SELECT

| WLS ₁ | WLS ₂ | I-Field Character Length |
|------------------|------------------|--------------------------|
| 0 | 0 | 5 bits |
| 1 | 0 | 6 bits |
| 0 | 1 | 7 bits |
| 1 | 1 | 8 bits |

b5 — **Transmit Abort (ABT)** — The ABT bit causes an Abort (at least 8 bits of "1" in succession) to be transmitted The Abort is initiated and the Tx FIFO is cleared when the control bit goes high. Once Abort begins, the Tx Abort control bit assumes the low state

b6 — **Abort Extend (ABT_{EX})** — If ABT_{EX} is set, the abort code initiated by ABT is extended up to at least 16 bits of consecutive "1's", the mark Idle State.

b7 — NRZI (Zero Complement)/NRZ Select (NRZI/NRZ) — NRZI/NRZ bit selects the transmit/receive data format to be NRZI or NRZ in both Loop Mode or Non-Loop mode operation. When the NRZI Mode is selected, a

1-bit delay is added to the transmitted data (TxD) to allow for NRZI encoding. 1...NRZI, 0...NRZ.

NOTE

NRZI coding — The serial data remains in the same state to send a binary "1" and switches to the opposite state to send a binary "0".

STATUS REGISTER

The Status Register #1 is the main status register. The IRQ bit indicates whether the ADLC requests service or not. The S2RQ bit indicates whether any bits in status register #2 request any service. TDRA and RDA, because they are most often used, are located in bit positions that are more convenient to test. RDA reflects the state of the RDA bit in status register #2.

The Status Register #2 provides the detailed status information contained in the S2RQ bit and these bits reflect receiver status. The FD bit is the only receiver status which is not indicated in status register #2

The prioritized status mode provides maximum efficiency in searching the status bits and indicates only the most important action required to service the ADLC. The priority trees of both status registers are provided in Figure 10.

Reading the status register is a non-destructive process. The method of clearing status depends upon the bit's function and is discussed for each bit in the register.

FIGURE 10 - STATUS REGISTER PRIORITY TREE (PSE = 1)



^{*}Prioritized even when PSE = 0 NOTE Status bit above will inhibit one below it

| STATUS REGISTER 1 (SR1) | | | | | | | | | | | |
|-------------------------|-----|-----|----|-----|----------|-----|-----|----|------|------|-----|
| | | | | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| RS1 | RS0 | R/W | AC | IRQ | TDRA/FC | TXU | CTS | FD | LOOP | S2RQ | RDA |
| 0 | 0 | 1 | × | | | | | | | | |
| | | | ļ | | <u> </u> | | | | | | |

b0 — Receiver Data Available (RDA) — The RDA status bit reflects the state of the RDA status bit in status register #2. It provides the means of achieving data transfers of received data in the full Duplex Mode without having to read both status registers.

b1 — Status Register #2 Read Request (S2RQ) — All the status bits (stored conditions) of status register #2 (except RDA bit) are logically ORed and indicated by the S2RQ status bit. Therefore, S2RQ indicates that status register #2 needs to be read. When S2RQ is "0", it is not necessary to read status register #2. The bit is cleared when the appropriate bits in status register #2 are cleared or when Rx Reset is used.

b2 — **Loop Status (LOOP)** — The LOOP status bit is used to monitor the loop operation of the ADLC. This bit does not cause an IRQ. When Non-Loop Mode is selected, LOOP bit stays "0". When Loop Mode is selected, the LOOP status bit goes to "1" during "On-Loop" condition. When ADLC is in an "Off-Loop" condition or "Go-Active-On-Poll" condition, the LOOP status bit is a "0"

b3 — **Flag Detected (FD)** — The FD Status bit indicates that a flag has been received if the Flag Detect Enable control bit has been set. The bit goes high at the last bit of the Flag Character received (when the Flag Detect Output goes low) and is stored until cleared by Clear Rx Status or Rx Reset

b4 — Clear-to-Send (CTS) — The $\overline{\text{CTS}}$ input positive transition is stored in the status register and causes an IRQ (if Enabled). The stored CTS condition and its IRQ are cleared by Clear Tx Status control bit or Tx Reset bit. After the stored status is reset, the CTS status bit reflects the state of the $\overline{\text{CTS}}$ input.

b5 — **Transmitter Underrun (TxU)** — When the transmitter runs out of data during a frame transmission, an underrun occurs and the frame is automatically terminated by transmitting an Abort. The underrun condition is indicated by the TxU status bit. TxU can be cleared by means of the Clear Tx Status Control bit or by Tx Reset

b6 — Transmitter Data Register Available/Frame Complete (TDRA/FC) — The TDRA Status bit serves two purposes depending upon the state of the Frame Complete/TDRA Select control bit. When this bit serves as a TDRA status bit, it indicates that data (to be transmitted) can be loaded into the Tx Data FIFO register. The first register (Register #1) of the Tx Data FIFO being empty (TDRA = "1") will be indicated by the TDRA Status bit in the "1-Byte Transfer Mode." The first two registers (Registers #1 and #2) must be empty for TDRA to be high when in the "2-Byte Transfer Mode." TDRA is inhibited by Tx Reset, or CTS being high.

When the Frame Complete Mode of operation is selected, the TDRA/FC status bit goes high when an abort is transmitted or when a flag is transmitted with no data in the Tx FIFO. The bit remains high until cleared by resetting the TDRA/FC control bit or setting the Tx Reset bit.

b7 — Interrpt Request (IRQ) — The Interrupt Request status bit indicates when the IRQ output is in the active state (IRQ Output = "0"). The IRQ status bit is subject to the same interrupt enables (RIE, TIE) as the $\overline{\text{IRQ}}$ output, i.e., with both transmitter and receiver interrupts enabled, the IRQ status bit is a logical ORed indication of Status Register 1 status bits. The IRQ bit only reflects the set status bits which have interrupts enabled. The IRQ status bit simplifies status inquiries for polling systems by providing single bit indication of service requests.

| STAT | STATUS REGISTER 2 (SR2) | | | | | | | | | | | | |
|------|-------------------------|-----|----|-----|------|-----|-----|-----|------|----|----|--|--|
| | | | | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | | |
| RS1 | RS0 | R/W | AC | RDA | OVRN | DCD | ERR | Rx | Rx | FV | ΑP | | |
| 0 | 1 | 1 | х | | | | | ABT | ldle | | | | |
| | | | | | | | | | | | | | |

- **b0** Address Present (AP) The AP status bit provides the frame boundary and indicates an Address octet is available in the Rx Data FIFO register. In the Extended Addressing Mode, the AP bit continues to indicate addresses until the Address field is complete. The Address present status bit is cleared by reading data or by Rx Reset.
- b1 Frame Valid (FV) The FV status bit provides the frame boundary indication to the MPU and also indicates that a frame is complete with no error. The FV status bit is set when the last data byte of a frame is transferred into the last location of the Rx FIFO (available to be read by MPU). Once FV status is set, the ADLC stops further data transfer into the last location of the Rx FIFO (in order to prevent the mixing of two frames) until the status bit is cleared by the Clear Rx Status bit or Rx Reset.
- **b2 Inactive Idle Received (Rx Idle)** The Rx Idle status bit indicates that a minimum of 15 consecutive "1's" have been received. The event is stored within the status register and can cause an interrupt. The interrupt and stored condition are cleared by the Clear Rx Status Control bit. The Status bit is the Logical OR of the receiver idling detector (which continues to reflect idling until a "0" is received) and the stored inactive idle condition.
- **b3 Abort Received (RxABT)** The RxABT status bit indicates that seven or more consecutive "11s" have been received. Abort has no meaning under out-of-frame conditions; therefore, no interrupt nor storing of the status will occur unless a Flag has been detected prior to the Abort. An Abort Received when "in frame" is stored in the status register and causes an IRQ. The status bit is the logical OR of the stored conditions and the Rx Abort detect logic, which is cleared after 15 consecutive "1's" have occurred. The stored

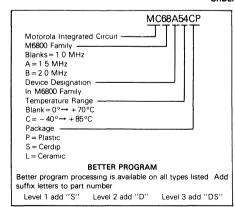
- Abort condition is cleared by the Clear Rx Status Control bit or Rx Reset.
- b4 Frame Check Sequence/Invalid Frame Error (ERR) When a frame is complete with a cyclic redundancy check (CRC) error or a short frame error (the frame does not have complete Address and Control fields), the ERR status bit is set instead of the Frame Valid status bit. Other functions, frame boundry indication and control function, are exactly the same as for the Frame Valid status bit. Refer to the FV status bit.
- **b5** <u>Data Carrier Detect (DCD)</u> A positive transition on the DCD input is stored in the status register and causes an IRQ (if enabled). The stored DCD condition and its IRQ are cleared by the Clear Rx Status Control bit or RX Reset. After stored status is reset, the DCD status bit follows the state of the input. Both the stored DCD condition and the DCD input cause the reset of the receiver section when they are high.
- **b6** Receiver Overrun (OVRN) OVRN status indicates that receiver data has been transferred into the Rx FIFO when it is full, resulting in data loss. The OVRN status is cleared by the Clear Rx Status bit or Rx Reset Continued overrunning only destroys data in the first FIFO Register.
- **b7** Receiver Data Available (RDA) The Receiver Data Available status bit indicates when receiver data can be read from the Rx Data FIFO. When the prioritized status mode is used, the RDA bit indicates that non-address and non-last data are available in the Rx FIFO. The receiver data being present in the last register of the FIFO causes RDA to be high for the "1-Byte Transfer Mode." The RDA bit being high indicates that the last two registers are full when in the "2-Byte Transfer Mode." The RDA status bit is reset automatically when data is not available

PROGRAMMING CONSIDERATIONS

- Status Priority When the prioritized status mode is used, it is best to test for the lowest priority conditions first.
 The lowest priority conditions typically occur more frequently and are the most likely conditions to exist when the processor is interrupted.
- 2. Stored vs Present Status Certain status bits (DCD, CTS, Rx Abort, and Rx Idle) indicate a status which is the logical OR of a stored and a present condition. It is the stored status that causes an interrupt and which is cleared by a Status Clear control bit. After being cleared, the status register will reflect the present condition of an input or a receiver input sequence.
- 3. Clearing Status Registers In order to clear an interrupt with the two Status Clear control bits, a particular status condition must be read before it can be cleared. In the prioritized mode, clearing a higher priority condition might result in another IRQ caused by a lower priority condition whose status was suppressed when a status register was first read. This guarantees that a status condition is never inadvertently cleared.
- 4. Clearing the Rx FIFO An Rx Reset will effectively clear the contents of all three Rx FIFO bytes. However, the FIFO may contain data from two different frames when abort or DCD failure occurs. When this happens, the data from a previously closed frame (a frame whose closing flag has been received) will not be destroyed.
- 5. Servicing the Rx FIFO in a 2-Byte Mode The procedure for reading the last bytes of data is the same, regardless of whether the frame contains an even or an odd number of bytes. Continue to read 2 bytes until an interrupt cocurs that is caused by an end-of-frame status (FV or ERR) When this occurs, indicating the last byte either has been read or is ready to be read, switch temporarily to the 1-byte mode with no prioritized status (control register 2).

- Test RDA to indicate whether a 1-byte read should be performed. Then clear the frame end status.
- 6. Frame Complete Status and RTS Release In many cases, a MODEM will require a delay for releasing RTS. An 8-bit or 16-bit delay can be added to the ADLC RTS output by using an Abort. At the end of a transmission, frame complete status will indicate the frame completion. After frame complete status goes high, write "1" into the Abt control bit (and Abt Extend bit if a 16-bit delay is required). After the Abt control bit is set, write "0" into the RTS control bit. The transmitter will transmit eight or sixteen "1's" and the RTS output will then go high (inactive).
- 7. Note to users not using the MC6800 (a) Care should be taken when performing a write followed by a read on successive E pulses at a high frequency rate. Time must be allowed for status changes to occur. If this is done, the time that E is low between successive write/read E pulses should be at least 500 ns. (b) The ADLC is a completely static part. However, the E frequency should be high enough to move data through the FIFOs and to service the peripheral requirements. Also, the period between successive E pulses should be less than the period of RxC or TxC in order to maintain synchronization between the data bus and the peripherals
- 8. Clear-to-Send (CTS) The CTS input, when high, provides a real-time inhibit to the TDRA status bit and its associated interrupt. All other status bits will be operational. Since it inhibits TDRA, CTS also inhibits the TDSR DMA request. The CTS input being high does not affect any other part of the transmitter. Information in the Tx FIFO and Tx Shift Register will, therefore, continue to be transmitted as long as the Tx CLK is running.

ORDERING INFORMATION



Level 1 "S" = 10 Temp Cycles - (-25 to 150°C), H Temp testing at T_A max Level 2 "D" = 168 Hour Burn-in at 125°C Level 3 "DS" = Combination of Level 1 and 2

| Speed | Device | Temperature Range |
|---------|---------------------------------|------------------------------|
| 1.0 MHz | MC6854P,L,S MC6854CP,CL,CS | 0 to 70°C - 40 to +85°C |
| 1 5 MHz | MC68A54P,L,S MC68A54CP,CL,CS | - 0 to +70°C -40 to +85°C |
| 2 0 MHz | MC68B54P,L,S | 0 to +70°C |



Product Preview

HMOS

(HIGH-DENSITY, N-CHANNEL SILICON-GATE)

MC6855 SERIAL DIRECT MEMORY ACCESS PROCESSOR

The Serial Direct Memory Access Processor is **intended** as a high-speed serial link between MPU's or other intelligent controllers. This device can automatically transfer data to or from memory and receive or transmit that data over a serial link. Using bit oriented protocols (i.e., SDLC, HDLC, X 25), the SDMAP is capable of handling multidrop, point-to-point, or loop configurations in a full or half duplex environment. Bit rates of up to 4 MHz full duplex can be used. The Data Link is configured with a primary SDMAP connected to one or more secondary SDMAP's. The primary station (SDMAP and its associated local MPU) has responsibility for the data link control, such as mode of operation and polling of the secondary SDMAP's. The secondary stations which are relatively transparent to the local MPU will respond only to link commands from the primary station. Each SDMAP has the ability to respond to link-level commands with automatic responses or station status and handle link level error recovery without intervention by the local MPU.

An internal DMA controller is contained in the SDMAP and is capable of handling both a transmit and receive channel simultaneously. The DMA controller is transparent to the user. The local MPU only needs to write the location of a parameter table to the SDMAP. This parameter table contains the start address, message length, type of message, etc. The SDMAP automatically reads and loads the parameters into it's internal registers and then starts to transmit (or receive) data

The SDMAP contains 7 control registers and 3 status registers. The control registers are used to configure the SDMAP, control reception and transmission of frames, and selectively mask interrupts. The status registers are used to monitor link activity, error conditions, and status of the SDMAP.

Other registers are included for local and group station addresses, test, I-frame counts (SDLC secondary only), and pointer registers used to define blocks of frames to transmit and blocks of receive buffers

- Up to 4 MHz Bit Rate
- External Data Recovery
- External Clocks
- DMA Chaining
- Automatic Processing of a Subset of SDLC Commands
- HDLC/SDLC Protocols
- Full/Half Duplex Operation
- DMA Capability
- Normal or System Address Detection
- MC6809 Compatibility
- NRZ Operation
- Internal Byte Synchronization
- Point-to-Point Mode
- Multidrop Mode
- Loop Mode
- Separately Powered Pass-Through Logic (Loop Mode)

MPU INTERFACE PINS

Power - The SDMAP uses a single supply with two pins dedicated to +5 V and two pins for ground

 $\overline{\text{RESET}}$ — The $\overline{\text{RESET}}$ pin is an input used to reset the SDMAF and place it in the Power-On-Reset mode

 R/\overline{W} (Read/Write) $-R/\overline{W}$ determines the direction of data transfers on the data bus for register or DMA accesses

DATA TRANSFERS

When DMAGNT is asserted and the DMAREQ was generated by the SDMAP, the R/W pin is generated as an output. The condition of the R/W pin (low or high) is dependent upon the direction of data as determined by the SDMAP. When DMAGNT is low, R/W is an input controlled by the external processor and determines the direction of data transfers to or from the SDMAP registers.

 $\overline{\text{IRQ}}$ (Output) $-\overline{\text{IRQ}}$ will be set low by the SDMAP to interrupt the MPU

 $\overline{\text{CS}}$ (Chip Select Input) — The $\overline{\text{CS}}$ input, in conjunction with the E input, is used to enable data transfers on D0-D7 E must be a high level and $\overline{\text{CS}}$ must be a low level to enable the transfer. The DMA Grant input being a high level performs a similar function as $\overline{\text{CS}}$ being a low level while in the DMA mode $\overline{\text{CS}}$ is invalid during a DMA cycle

E Clock (Input) — The E input to the SDMAP causes data transfers to occur between the SDMAP and the system controlling the SDMAP (MC6809 MPU, etc.)

Q (Quadrature Clock Input) — Q is an input to the SDMAP which precedes E by 90 degrees. It is used as an internal timing signal

DMAR (DMA Request Output) — The DMAR is developed at the rising edge of Q to request the bus for data transfer DMAR is dropped during Q.

DMAGNT (DMA Grant Input) — DMAGNT goes active on the falling edge of E placing the MPU bus in a 3-state mode and allowing the requesting device to become a bus master DMAGNT takes the place of CS when in a DMA operation

A0-A15 (Address Bus Bidirectional) — A0-A15, in conjunction with the R/\overline{W} input, are used to select one of the MPU accessible registers in the SDMAP for programmed data transfer.

During any DMA operation A0-A15 are ignored as register

select inputs and are used only as outputs to select the proper memory location

D0-D7 (Data Bus Bidirectional) — The 8 bidirectional data lines allow the transfer of data between the SDMAP and the controlling system

 \mbox{MCLK} – The MCLK input supplied to the SDMAP is a crystal controlled 8 MHz clock used to supply the internal timing of the SDMAP

MRDY (Memory Ready Output) — MRDY is output by the SDMA to stretch the falling edge of E during a register read or write operation to allow time for the data to be stable on the data bus prior to the falling edge of E

<u>DMAVMA</u> (DMA Valid Memory Address Output) — DMAVMA goes low at the beginning of a DMA cycle to allow time for one controlling device to release the bus and another device to become the bus master <u>DMAVMA</u> goes to zero on the rising edge of DMAGNT and returns to a one state on the next falling edge of E It is during this time that address lines are allowed to switch

TDATA (Transmit Data Output) — TDATA is the serial bit stream sent by the SDMAP in a synchronous format TDATA is shifted out in an NRZ format on the negative edge of TXCLK

TXCLK (Transmit Clock Input) — TXCLK is an input to the SDMAP generated by an external crystal oscillator source This input takes standard TTL levels and is a X1 input

RDATA (Receive Data Input) — RDATA is the serial bit stream received by the SDMAP in a synchronous format The RDATA is synchronized externally to the RXCLK and is strobed into the SDMAP on the positive edge of the clock The SDMAP requires the data to be input in an NRZ data format

RXCLK (Receive Clock Input) — RXCLK is an input to the SDMAP generated by an external crystal oscillator source. It is a standard TTL level externally synchronized to the receive data and strobes the data into the SDMAP on the positive edge of the X1 Receive Clock.

 $\overline{\textbf{RTS}}$ (Request to Send Output) — The $\overline{\textbf{RTS}}$ pin, when used in systems requiring modems, signals the modem to turn on the transmit carrier and initiate the return of $\overline{\textbf{CTS}}$ In systems not requiring modems, $\overline{\textbf{RTS}}$ is used as needed to control the flow of data on the serial line



MC6859

Advance Information

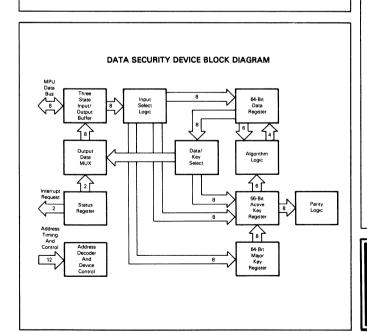
DATA SECURITY DEVICE

The MC6859 Data Security Device (DSD) is a monolithic MOS integrated circuit designed to be integrated into a wide range of equipment requiring protection of data by the employment of cryptographic measures

The cryptographic algorithm utilized by the device is the Data Encryption Standard (DES) as adopted by the U.S. Department of Commerce, National Bureau of Standards (NBS), in publication FIPS PUB 46 (1-15-1977)

Through the use of flexible on-chip control and status circuitry and external control lines, the DSD provides direct capability of adapting the functional implementation of the DES algorithm for various specific system requirements for data protection.

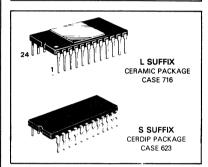
- Direct Compatibility with the M6800 Microprocessor Family
- Data Encryption Standard Algorithm
- Two Separate Interrupt Output Lines for Program Controlled Interrupt Capability
- Up to 400 KBPS Throughput Rate of 64-Bit Block Cipher (Exclusive of Software Overhead)
- TTL Compatible
- Single +5 V Power Supply

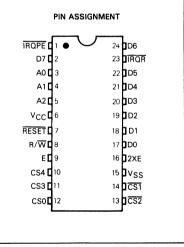


MOS

DEPLETION LOAD
(N-CHANNEL, SILICON-GATE)

DATA SECURITY DEVICE





NOTICE

This product may not be exported without prior approval from the U.S. Department of State, Office of Munitions Control.

MAXIMUM RATINGS

| Characteristics | Symbol | Value | Unit |
|--|------------------|--|------|
| Supply Voltage | VCC | -03 to +70 | ٧ |
| Input Voltage | V _{in} | -0.3 to +7.0 | V |
| Operating Temperature Range MC6859 MC6859C | TΑ | T _L to T _H 0 to 70 - 40 to +85 | °C |
| Storage Temperature Range | T _{stg} | - 55 to + 150 | °C |

THERMAL CHARACTERISTICS

| Characteristic | Symbol | Value | Unit |
|---------------------------------------|--------|-------|------|
| Thermal Resistance Ceramic Package | θJA | 60 | °C/W |
| Cerdip Package | | 65 | ! |

This device contains circuitry to protect the inputs against damage due to high static voltages or electric fields, however, it is advised that normal precuations be taken to avoid application of any voltage higher than maximum rated voltages to this high-impedance circuit. Reliability of operation is enhanced if unused inputs are tied to an appropriate logic voltage level (e.g., either VSS or VCC)

POWER CONSIDERATIONS

The average chip-junction temperature, TJ, in °C can be obtained from

$$T_{J} = T_{A} + (P_{D} \bullet \theta_{JA}) \tag{1}$$

Where.

TA = Ambient Temperature, °C

θ_{JA} ≡ Package Thermal Resistance, Junction-to-Ambient, °C/W

PD≡PINT+PPORT

PINT≡ICC×VCC, Watts - Chip Internal Power

PPORT = Port Power Dissipation, Watts - User Determined

For most applications PPORT ◀PINT and can be neglected PPORT may become significant if the device is configured to drive Darlington bases or sink LED loads.

An approximate relationship between PD and TJ (if PPORT is neglected) is

$$P_D = K + (T_J + 273 °C)$$
 (2)

Solving equations 1 and 2 for K gives:

$$K = P_D \bullet (T_A + 273^{\circ}C) + \theta_{JA} \bullet P_D^2$$
(3)

Where K is a constant pertaining to the particular part. K can be determined from equation 3 by measuring P_D (at equilibrium) for a known T_A . Using this value of K the values of P_D and T_J can be obtained by solving equations (1) and (2) iteratively for any value of T_A

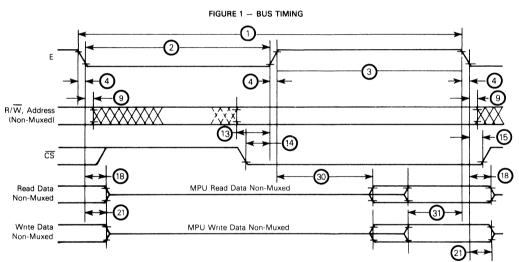
DC ELECTRICAL CHARACTERISTICS (V_{CC}=5 0 Vdc ±5%, V_{SS}=0, T_A=T₁ to T_H, unless otherwise noted)

| Characteristic | | Symbol | Min | Тур | Max | Unit |
|---|----------------------|------------------|----------------------|------|--|------|
| Input High Voltage | | VIH | V _{SS} +20 | _ | Vcc | ٧ |
| Input Low Voltage | | VIL | V _{SS} -03 | _ | V _{SS} +08 | ٧ |
| Input Leakage Current (V _{In} = 0 to 5 25 V) | | lin | _ | 10 | 2 5 | μA |
| Three-State (Off State) Input Current (V _{In} = 0 to 5 25 V) | D0-D7 | ΙΙΖ | - | 20 | 10 | μΑ |
| Output High Voltage ($I_{Load} = -205 \mu A$) (See Figure 2) | D0-D7 | Voн | V _{SS} + 24 | _ | _ | ٧ |
| Output Low Voltage (I _{Load} = 1 6 mA) (I _{Load} = 3 2 mA) (See Figure 2) | D0-D7 IRQPE, IRQR | V _{OL} | - | - | V _{SS} +04 V _{SS} +06 | ٧ |
| Output Leakage Current (Off State) (VOH = 2 4 V) | IRQPE, IRQR | loz | _ | 10 | 10 | μΑ |
| Internal Power Dissipation (Measured at $T_A = T_L$) | | PINT | _ | 1000 | _ | mW |
| Input Capacitance ($V_{IN} = 0$, $T_A = 25$ °C, $f = 1$ 0 MHz) | D0-D7 All Others | C _{in} | _ | _ | 12 5 7 5 | pF |
| Output Capacitance (V _{In} = 0, T _A = 25 °C, f = 1 0 MHz) | IRQPE, IRQR | C _{out} | - | _ | 50 | pF |

BUS TIMING CHARACTERISTICS (See Notes 1 and 2)

| Characteristic | Symbol | MC6859 | | MC68A59 | | MC68B59 | | Unit |
|---------------------------------|---|--|-------------------------------|--|---|--|--|--|
| Characteristic | Symbol | Min | Max | Min | Max | Mın | Max | J |
| Cycle Time | t _{cyc} | 10 | 10 | 0 67 | 10 | 05 | 10 | μS |
| Pulse Width, E Low | PWEL | 430 | | 280 | _ | 210 | - | ns |
| Pulse Width, E High | PWEH | 450 | _ | 280 | _ | 220 | _ | ns |
| Clock Rise and Fall Time | | - | 25 | - | 25 | - | 20 | ns |
| Address Hold Time | t _A H | 10 | - | 10 | _ | 10 | _ | ns |
| Address Setup Time Before E | †AS | 80 | _ | 60 | - | 40 | _ | ns |
| Chip Select Setup Time Before E | tcs | 80 | _ | 60 | | 40 | _ | ns |
| Chip Select Hold Time | tCH | 10 | - | 10 | _ | 10 | _ | ns |
| Read Data Hold Time | | 20 | 100 | 20 | 100 | 20 | 100 | ns |
| Write Data Hold Time | tDHW | 10 | - | 10 | _ | 10 | _ | ns |
| Output Data Delay Time | tDDR | - | 290 | | 180 | - | 150 | ns |
| Input Data Setup Time | tDSW* | 165 | _ | 80 | - | 60 | - | ns |
| | Pulse Width, E Low Pulse Width, E High Clock Rise and Fall Time Address Hold Time Address Setup Time Before E Chip Select Setup Time Before E Chip Select Hold Time Read Data Hold Time Write Data Hold Time Output Data Delay Time | Cycle Time t _{Cyc} Pulse Width, E Low PWEL Pulse Width, E High PWEH Clock Rise and Fall Time t _r , t _f Address Hold Time tAH Address Setup Time Before E t _{CS} Chip Select Setup Time Before E t _{CS} Chip Select Hold Time t _C H Read Data Hold Time t _D HR Write Data Hold Time t _D HW Output Data Delay Time t _D DR | Characteristic Symbol Min | Characteristic Symbol Min Max Cycle Time t _{CyC} 1 0 10 Pulse Width, E Low PWEL 430 - Pulse Width, E High PWEH 450 - Clock Rise and Fall Time t _I , t _I - 25 Address Hold Time t _A H 10 - Address Setup Time Before E t _{CS} 80 - Chip Select Setup Time Before E t _{CS} 80 - Chip Select Hold Time t _C H 10 - Read Data Hold Time t _{DHR} 20 100 Write Data Hold Time t _{DHW} 10 - Output Data Delay Time t _{DHW} - 290 | Characteristic Symbol Min Max Min Min Cycle Time tcyc 1 0 10 0 67 | Characteristic Symbol Min Max Mi | Characteristic Symbol Min Max Mi | Characteristic Symbol Min Max Mi |

^{*}See Mask Sets for mask set AK6 Data Setup time



Notes

- 1 Voltage levels shown are V_L \leq 0 4 V, V_H \geq 2 4 V, unless otherwise specified 2 Measurement points shown are 0 8 V and 2 0 V, unless otherwise specified

FIGURE 2 - BUS TIMING TEST LOADS

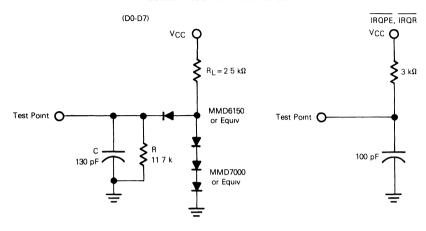
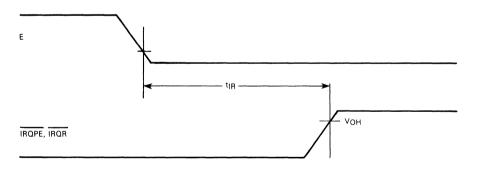


FIGURE 3 - INTERRUPT RELEASE TIME



Note Timing measurements are referenced from a low voltage of 0.8 volts and a high voltage of 2.0 volts, unless otherwise noted

BUS INTERFACE

The MC6859 Data Security Device (DSD) interfaces to the M6800 bus via an 8-bit bidirectional data bus, five chip select lines, a read/write (R/ \overline{W}) line, an external \overline{RESET} line, three register select lines, an Enable (System ϕ 2) line, a 2XEnable (2XE) clock line, and two interrupt request lines. These signals permit the M6800 MPU to control the DSD and perform data transfers between the two

Bidirectional Data Bus (D0-D7) — The bidirectional data lines (D0-D7) allow the transfer of information between the MPU and DSD. The data bus input/output drivers are three-state devices which remain in the high-impedance (off) state except when the MPU performs a DSD read or write operation.

Chip Select (CS0, $\overline{\text{CS1}}$, $\overline{\text{CS2}}$, CS3, and CS4) — These five signals are used to activate the data bus interface and allow DSD data transfers When CS0=CS3=CS4=1 and $\overline{\text{CS1}}$ = $\overline{\text{CS2}}$ =0, the device is selected

Read/Write (R/W) — With the DSD selected, this input controls the direction of data transfer on the data bus. When R/W is high, data in the DSD is read by the MPU on the trailing edge of E. A low state on the R/W line enables data transfer from the MPU on the trailing edge of the 2XE signal on the AK6 mask set and on the trailing edge of E for all other mask sets. (See Mask Sets.)

Enable (E) and 2XEnable (2XE) — The rising edge of the Enable input initiates data transfer from the DSD to the MPU during a read cycle. The falling edge of the Enable input latches MPU data into the DSD during a write cycle. The 2XE input is used in processing the encryption/decryption algorithm for all mask sets. E and 2XE are completely asynchronous. See section on Mask Sets for exceptions on prior revision of the DSD.

Reset (RESET) — This input signal is used to initialize the internal control logic, status flags, and counters of the DSD The contents of the active key register and major key register remain unchanged. The RESET function should be coupled with the system power-on reset to provide orderly system initialization. It may also be used as a master reset to the chip during system operation.

To abort the encryption algorithm before the required 320 clock cycles (2XE) have occurred, it is necessary to provide a RESET signal or a software reset command to the DSD When this occurs, information in the data register and active key register is no longer valid. The contents of the major key register are unaffected.

Address Lines (A0, A1, A2) — These inputs are used in conjunction with the R/\overline{W} line to select one of eleven possible DSD operations, as shown in Tables 1 and 2. The DSD is accessed via MPU read and write operations in much the same manner as a memory device

NOTE:

Instructions performing operations directly on memory should not be used when the DSD is accessed. Since the DSD uses the R/ \overline{W} line as an additional register select input, read-modify-write type instructions will conflict with normal operation of the Data Security Device

Modes — Operational and control modes are invoked by addressing DSD registers at the addresses in Tables 1 and 2

TABLE 1 - OPERATIONAL MODES

| Co | Control Address | | | Operational Mode | | | |
|-----|-----------------|----|-----|--|--|--|--|
| A0, | A1, | A2 | R/W | Operational Mode | | | |
| 0 | 0 | 0 | W | Write Data/"C" Key Operation (1st 7 bytes) | | | |
| •1 | 0 | 1 | w | Encipher Data | | | |
| •0 | 0 | 1 | w | Decipher Data | | | |
| 0 | 0 | 1 | R | Read Data | | | |
| 0 | 1 | 0 | R | Read Status | | | |

TABLE 2 - CONTROL MODES

| Control Address | | dress | Control Mode | | |
|-----------------|-----|-------|--------------|---------------------------|--|
| A0, | A1, | A2 | R/W | Control Mode | |
| 1 | 0 | 0 | W | Reset/Initialize | |
| 0 | 1 | 0 | W | Enter Major Key | |
| 1 | 1 | 0 | W | Enter Plain Secondary Key | |
| •0 | 1 | 1 | W | Decipher Secondary Key | |
| •1 | 1 | 1 | w | Encipher Secondary Key | |
| 1 | 0 | 0 | R | Transfer Major Key | |

^{*}Instruction initiated after eighth byte of Key Block entry

Interrupt Requests — These open drain outputs are used to convey internal DSD status information to the MPU.

Ready Interrupt Request ($\overline{\text{IRQR}}$) — This active low output signals the MPU that the DSD is ready to initiate another operation. The $\overline{\text{IRQR}}$ signal will be inactive during encryption/decryption or key transfer.

Parity Error Interrupt Request (IRQPE) — This active low output is used to signal the MPU that the DSD has detected a parity error. The IRQPE signal will remain low until a hardware or software reset is received.

DSD FUNCTIONAL DESCRIPTION

The MC6859 Data Security Device appears to an MPU system as an interface adapter device. An example of a system with the encryption function is shown in Figure 4.

Internal construction of the DSD is illustrated by the block diagram. The device consists of a single 8-bit data bus buffer with three-state operation, through which data may be entered into

- 1) the 56-bit active key register
- 2) the 64-bit major key register
- 3) the 64-bit data register

Output data from the status register or the data register is also switched through the data bus buffers

At the bus interface, the DSD data register appears as eight addressable memory locations to the MPU, through which the operational mode of the chip may be selected, chip status monitored, key or data written into the device, and data read from the device

OPERATING MODES

As shown in Table 1, the operation of the DSD is split into five major modes:

- 1) status readout
- 2) loading of data or encrypted key
- 3) data encryption
- 4) data decryption
- 5) data readout

These and additional control modes are activated by three address input lines and a read/write input line.

Read Status — Only two bits are used in the status readout, D7=Parity Error (PE) and D6= \overline{READY} The remaining six bits are always read as logic zeros. A read of the status register does not change these bits.

The PE flag is set when a parity error is detected while loading either a major or secondary key or when the active key is checked during algorithm operation. The PE flag remains set and the \overline{IRQPE} signal will remain low until a hardware/software reset is received.

The $\overline{\text{READY}}$ flag is set and the $\overline{\text{IRQR}}$ output goes high whenever the device is processing a block of data. The flag is cleared, pulling the $\overline{\text{IRQR}}$ output low, whenever the DSD is necessary encoding/decoding data or transferring major key $\overline{\text{IRQR}}$ may be tied to $\overline{\text{IRQ}}$ of a M6800 family processor for interrupt-driven encryption if no other peripherals share the $\overline{\text{IRQ}}$ line.

Encipher Data — To encipher an 8 byte block of data, the first seven bytes are written to the Write Data/"C" Key register. The eighth byte is written to the Encipher Data register. This automatically initiates the encryption process.

Data is always processed using the current Active Key During algorithm operation, the DSD constantly performs parity checking on the contents of the active key register. The busy flag will be set during encryption and then reset when the algorithm has finished. Completion requires 320 cycles of 2XE. During this time the DSD will ignore all external commands except status read, hardware reset and software reset.

Decipher Data — This process is identical to encipher data except that the eighth byte is written to the Decipher Data register. During decipher or encipher only a read status register, hardware reset, or software reset will be recognized. All other commands will be ignored.

Read Data — This command is normally executed upon completion of the encipher/decipher algorithm (indicated by READY = 0). A read prior to completion of busy will result in all zeros being read from D0-D7. As each byte of data is read, zeros are automatically shifted into the data register to ensure data security.

CONTROL MODES

Shown in Table 2 are the control modes which facilitate programming of the primary and secondary keys

Reset/Initialize — The DSD may be software reset by writing the reset/initialize command at any time the data bus is ignored. Like the hardware reset, this command initializes the internal control logic, status flags, and counters without altering the contents of the active key register or the major key register. If a hardware or software reset is issued during the algorithm processing, the information in the data register and active key register will no longer be valid. However, the contents of the major key register are not affected.

M6800 Microprocessor Data Bus Address Rus Peripheral Communications Read Only Interface Interface Memory Adapter Adapter Random Data Access Security Modem Memory Device

FIGURE 4 - M6800 MICROCOMPUTER FAMILY BLOCK DIAGRAM

Load Major Key — An unencrypted key will be entered into both the active key register and the major key register when eight consecutive bytes are written into the Enter Major Key Register Parity error checking is automatically performed.

Load Plain Secondary Key — An unencrypted key may be loaded into the active key register and simultaneously checked for parity errors by writing eight consecutive bytes into the Enter Plain Secondary Key Register The Major Key Register is unaffected

Encipher Secondary Key — After a secondary key is loaded, it can be enciphered or deciphered (the source of an encypted key is usually another DSD). A secondary key may be enciphered by loading the first seven bytes of plain text to the Write Data/"C" Key register. The eighth byte is entered to the Encipher Secondary Key register. This causes the secondary key to be enciphered using the current major key and automatically loaded into the Active Key register and checked for parity. This operation requires 328 cycles of 2XE.

Decipher Secondary Key — This function is similar to the Encipher Secondary Key operation. The first seven bytes of the key are loaded into the Write Data/"C" Key register. The eighth byte is entered by addressing the Decipher Secondary Key register. The secondary key is then deciphered using the current major key and automatically loaded into the Active Key register and checked for parity. This operation requires 328 cycles of 2XE.

Transfer Major Key — The contents of the Major Key register will be transferred to the Active Key register by a read of the Transfer Major Key register The data bus is ignored. The Major Key register remains unchanged. This operation requires eight cycles of 2XE.

KEY CONVENTIONS

The key used for coding is a 56-bit data word plus eight bits of odd parity. In the DSD seven bits of key and the parity bit make up a key character. Eight key characters make up the total key information required by the DSD if parity errors are to be checked via the PE signal. If parity is not needed for some reason, then the parity bit need not be calculated and can be left as a zero. An example key with parity is shown in Table 3.

TABLE 3 - EXAMPLE KEY

| Key Character | Hex Value | | E | Bina | ry \ | /alu | е | | Parity |
|------------------------------------|-----------|---|---|------|------|------|---|---|--------|
| Byte 1 | 7C | 0 | 1 | 1 | 1 | 1 | 1 | 0 | 0 |
| Byte 2 | A1 | 1 | 0 | 1 | 0 | 0 | 0 | 0 | 1 |
| Byte 3 | 10 | 0 | 0 | 0 | 1 | 0 | 0 | 0 | 0 |
| Byte 4 | 45 | 0 | 1 | 0 | 0 | 0 | 1 | 0 | 1 |
| Byte 5 | 4A | 0 | 1 | 0 | 0 | 1 | 0 | 1 | 0 |
| Byte 6 | 1A | 0 | 0 | 0 | 1 | 1 | 0 | 1 | 0 |
| Byte 7 | 6E | 0 | 1 | 1 | 0 | 1 | 1 | 1 | 0 |
| Byte 8 | 57 | 0 | 1 | 0 | 1 | 0 | 1 | 1 | 1 |
| Data Lines D7 D6 D5 D4 D3 D2 D1 D0 | | | | | | | | | |

TYPICAL SYSTEM OPERATION

For a communications link between a sender and one or

more receivers, the following typical sequence might be used to transmit confidential data

- 1) A software reset is issued to each DSD by its MPU
- The sending MPU loads a major key (eight bytes) into its DSD. This will serve as the active key if a secondary key is not entered
- 3) The receiving station must also load this same major key before data transmission can begin. If the current major (or secondary) key is not known in advance, it can be transmitted by the sending MPU, but may not be encoded as the receiving MPU system has no key to decode it by The MPU at the receiving station must be programmed with the mode and format being used for data transmission so its DSD can process the data correctly At this point both the transmitting and receiving stations are ready for data transfer
- 4) The sending MPU writes eight bytes of data into its DSD which enciphers them
- 5) The sending MPU retrieves eight bytes of encrypted data from its DSD and transmits them to the receiving MPU
- 6) The receiving MPU writes these eight bytes of data into its DSD to be deciphered
- 7) The receiving MPU retrieves eight bytes of data from its DSD in the original plain text form.

Steps four through seven are repeated for each 8-byte block of data to be transmitted. If the major key or secondary key is to be changed, steps two and three must also be carried out.

SECURITY CONSIDERATIONS

The security of a system employing the NBS Data Encryption Standard (DES) depends only upon the key used, not the availability of the algorithm or of equipment used to implement the algorithm. The key is the most critical piece of information in the system and security of the key itself must be maintained both inside and outside the system.

Guidelines to be used in selecting a key are

- Consider the key to be a single 56-bit number
- Avoid bias in selecting the key
- Change key as frequently as practical

One way to help ensure the security of the key is to make frequent use of secondary keys. Secondary keys can be generated by the sender and distributed selectively to one or more receivers. Since the MC6859 can encipher or decipher secondary keys using the major key, the sender can transmit the secondary key in encrypted form to further ensure system security. However, the receiver must be aware that a secondary key is being transmitted and must decrypt the key if it was sent in encrypted form.

Assuming that secrecy of the key is maintained, it is nearly impossible for an unauthorized user to decode an intercepted message into its original form. Since the DES algorithm utilizes a 56-bit active key, there are 2^{56} (or about 7×10^{16}) possible encrypted messages which must be searched to retrieve the original message. In addition, if the key were changed regularly only a small portion of the message would be retrieved for each successful exhaustive search. Therefore, the basic "block cipher" technique described in the Typical System Operation section is adequate for today's data security applications

If additional security is required for some reason, several techniques can be used to increase data security. These include

- Perform multiple encryption and/or decryption using the same key or different keys
- Reverse the algorithm (decipher-transmit-encipher)
- Utilize cipher feedback or other feedback techniques

The process of multiple encryption or decryption is an easy way to effectively increase the size of the key to any desired length. For example, the sender might successively encipher, decipher, and encipher a block of data using one key for the encipher operations and another for the decipher operation. The receiver would then have to decipher, encipher, and decipher the data using the same pair of keys. This technique would greatly increase data security while reducing throughput by a factor of three. Many such multiple encryption combinations are possible.

An easy way to increase security without reducing throughput is to perform the DES algorithm "in reverse". In other words, data or keys can be deciphered by the sender and then enciphered by the receiver to yield the original message. This technique works because the enciphering and deciphering algorithms are "mirror images" of each other.

Many different feedback techniques are available as alternatives to the basic 64-bit block cipher. One of these, known as cipher feedback (CFB), is described below. CFB is a byteoriented implementation in that only one byte is transmitted at a time. Thus, throughput is reduced by a factor of eight (excluding software overhead). Implementation of the CFB technique is more dependent upon the system configuration than is the block cipher.

CFB ENCIPHER

The basic flow of the CFB encipher procedure is shown in Figure $\mathbf{5}$

An initial eight byte fill of the RAM buffer must be done prior to accepting plain text bytes for enciphering. This information can be considered to be a data subset of the key, but may be any combination of eight-bit bytes as long as the deciphering device uses the same initial fill.

After the block of data in the RAM buffer is enciphered, one byte of enciphered data is read from the DSD. This byte is the key byte (Kt+1). The plain text byte (Pt+1) is exclusive ORed with the key byte and the result is the cipher text byte (Ct+1). The cipher text byte is shifted into the bottom of the RAM buffer and now is the newest byte in the block. The oldest previous byte is discarded. The cipher text byte is now available for use. The new RAM buffer block is loaded into the DSD for enciphering and yields the next key for further processing.

CFB DECIPHER

The basic flow of the decipher CFB operation is shown in Figure 6

The same initial fill as used for enciphering must be used to initialize the decipher RAM buffer. The same key used to encipher must also be used to load the DSD active key register prior to receiving cipher text bytes. When a cipher text byte is received it is exclusive ORed with the key byte generated by the DSD and the result is the plain text data byte. The received cipher text byte is shifted into the RAM buffer and becomes the newest RAM buffer byte. The oldest RAM buffer byte is discarded and the eight byte RAM buffer is loaded into the DSD for block deciphering. One byte of the DSD data register is read out and this byte becomes the key byte for the next cipher text byte received.

FIGURE 5 — CFB ENCIPHER DATA FLOW (TRANSMITTING)

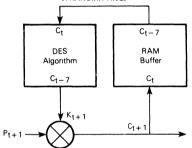
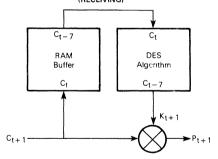


FIGURE 6 — CFB ENCIPHER DATA FLOW (RECEIVING)



To purchase a copy of the NBS Data Encryption Standard ask for the Federal Information Processing Standards (FIPS) Publication, FIPSP 46 at the following address

National Technical Information Service U.S. Department of Commerce 5285 Port Royal Road

Springfield, VA 22161

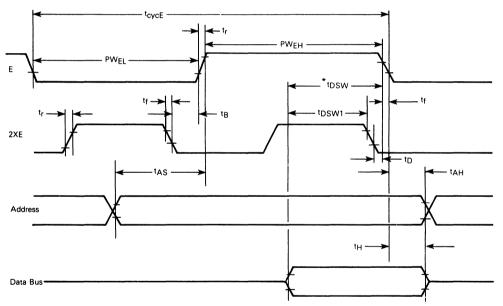
MASK SETS

Devices marked "AK6XXXX", where "AK6" is the mask set designation, latch MPU data into the DSD on the falling edge of 2XEnable during a write cycle as shown in Figure 7 E and 2XE must be synchronized. Devices marked with a mask set designation other than "AK6" latch MPU data into the DSD on the falling edge of Enable during a write operation as described in this data sheet. This is the only operational difference between devices manufactured using the

old "AK6" mask set and those using the more recent mask sets.

The change to the "AK6" mask set allows the user to treat the DSD like any other M6800 peripheral since all data transfers are referenced to the Enable clock E and 2XE are asynchronous on all mask sets except AK6. For this reason devices will no longer be produced using the "AK6" mask set. The "AK6" mask set can be identified by the "AK6" designation preceding the data code on top of the package

FIGURE 7 — BUS WRITE TIMING CHARACTERISTICS (WRITE INFORMATION INTO DSD) (AK6 MASK SET ONLY)



*Data is latched into the internal registers on the falling edge of 2XE and while Enable is high. Therefore, for system considerations to topsw1+tp+2X tf Minimize tp to ensure operation at 1 MHz tpsw1 is the data setup time for the "AK6" mask set

Note Timing measurements are referenced to and from a low voltage of 0.8 volts and a high voltage of 2.0 volts, unless otherwise noted

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MC6860

0-600 bps DIGITAL MODEM

The MC6860 is a MOS subsystem designed to be integrated into a wide range of equipment utilizing serial data communications

The modem provides the necessary modulation, demodulation and supervisory control functions to implement a serial data communications link, over a voice grade channel, utilizing frequency shift keying (FSK) at bit rates up to 600 bps. The MC6860 can be implemented into a wide range of data handling systems, including stand alone modems, data storage devices, remote data communication terminals and I/O interfaces for minicomputers.

N-channel silicon-gate technology permits the MC6860 to operate using a single-voltage supply and be fully TTL compatible

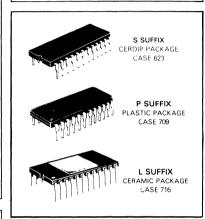
The modem is compatible with the M6800 microcomputer family, interfacing directly with the Asynchronous Communications Interface Adapter to provide low-speed data communications capability

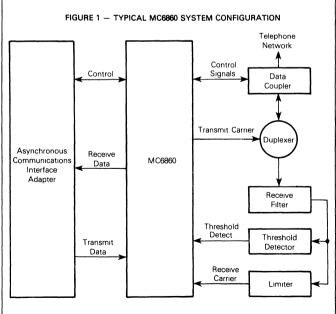
- Originate and Answer Mode
- Crystal or External Reference Control
- Modem Self Test
- Terminal Interfaces TTL-Compatible
- Full-Duplex or Half-Duplex Operation
- Automatic Answer and Disconnect
- Compatible Functions for 100 Series Data Sets
- Compatible Functions for 1001A/B Data Couplers

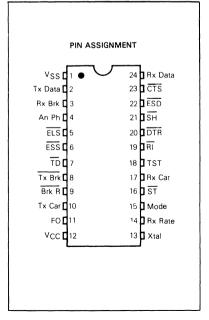
MOS

(N-CHANNEL, SILICON-GATE)

0-600 bps
DIGITAL MODEM







MAXIMUM RATINGS

| Rating | Symbol | Value | Unit |
|---|------------------|---|------|
| Supply Voltage | Vcc | -0.3 to +7.0 | ٧ |
| Input Voltage | V _{in} | -03 to +70 | V |
| Operating Temperature Range MC6860 MC6860S, MC6860C | ТА | T _L to T _H 0 to 70 -40 to +85 | °C |
| Storage Temperature Range | T _{stg} | - 55 to + 150 | °C |

This device contains circuitry to protect the inputs against damage due to high static voltages or electric fields, however, it is advised that normal precautions be taken to avoid application of any voltage higher than maximum rated voltages to this high impedance circuit

Reliability of operation is enhanced if unused inputs are tied to an appropriate logic voltage level (e g , either VSS or VCC)

(3)

THERMAL CHARACTERISTICS

| Characteristics | Symbol | Value | Unit |
|--------------------|---------------|-------|--------|
| Thermal Resistance | | | |
| Cerdip | | 65 | l∘c/w |
| Plastic | θ_{JA} | 120 | 1-0/00 |
| Ceramic | į | 60 | 1 |

POWER CONSIDERATIONS

The average chip-junction temperature, TJ, in °C can be obtained from

$$T_{J} = T_{A} + (P_{D} \cdot \theta_{JA}) \tag{1}$$

Where

TA = Ambient Temperature, °C

θ.jA ≡ Package Thermal Resistance, Junction-to-Ambient, °C/W

PD = PINT + PPORT

 $P_{INT} = i_{CC} \times V_{CC}$, Watts - Chip Internal Power

PPORT = Port Power Dissipation, Watts - User Determined

For most applications PPORT ≪PINT and can be neglected PPORT may become significant if the device is configured to drive Darlington bases or sink LED loads

An approximate relationship between PD and TJ (if PPORT is neglected) is

$$P_{D} = K - (T_{J} + 273 ^{\circ}C) \tag{2}$$

Solving equations 1 and 2 for K gives $K = PD \bullet (TA + 273 \circ C) + \theta JA \bullet PD^2$

for a known TA. Using this value of Kitle values of PD and TJ can be obtained by solving equations (1) and (2) iteratively for any value of TA

DC ELECTRICAL CHARACTERISTICS

(V_CC=5 0 ±5% Vdc, all voltages referenced to V_{SS}=0, T_A=T_L to T_H, all outputs loaded as shown in Figure 2 unless otherwise noted)

| Characteristic | Symbol | Min | Тур | Max | Unit |
|--|----------------------------------|------|------|--------------|------------------|
| Input High Voltage, All Inputs Except Crystal | V _{IH} | 20 | - | Vcc | ٧ |
| Input Low Voltage, All Inputs Except Crystal | VIL | VSS | _ | 0 80 | V |
| Crystal Input Voltage (Crystal Input Driven from an External Reference, Input Coupling Capacitor= 200 pF, Duty Cycle= $50\pm5\%$) | V _{in} | 15 | - | 2 0 | V _{p-p} |
| | l _{in} | _ | - | -02 -16 | mA |
| Input Leakage Current (V _{In} = 7 0 V, V _{CC} = V _{SS} , T _A = 25°C) | IIL | - | _ | 10 | μΑ |
| Output High Voltage, All Outputs Except An Ph and Tx Car $(I_{OH1} = -0.04 \text{ mA}, Load A)$ | V _{OH1} | 2 4 | - | vcc | V |
| Output Low Voltage, All Outputs Except An Ph and Tx Car (IOL1 = 1 6 mA, Load A) | V _{OL1} | Vss | _ | 0 40 | V |
| Output High Current, An Ph (VOH2=08 V, Load B) | IOH2 | 0 30 | - | _ | mA |
| Output Low Voltage, An Ph (I _{OL2} =0, Load B) | VOL2 | Vss | - | 0 30 | V |
| Input Capacitance (f = 0 1 MHz, T _A = 25°C) | C _{in} | - | 50 | | pF |
| Output Capacitance (f = 0 1 MHz, T _A = 25°C) | C _{out} | _ | 10 | _ | pF |
| Transmit Carrier Output Voltage (Load C) | Vco | 0 20 | 0 35 | 0 50 | V(RMS) |
| Transmit Carrier Output 2nd Harmonic (Load C) | V _{2H} | - 25 | - 32 | _ | dB |
| Input Transition Times, All Inputs Except Crystal (Operating in the Crystal Input Mode, from 10% to 90% Points) | t _r t _f | _ | _ | 1 0* 1 0* | μS |
| Input Transition Times, Crystal Input (Operating in External Input Reference Mode) | t _r t _f | _ | - | 30 30 | ns |
| Output Transition Times, All Outputs Except Tx Car (From 10% to 90% Points) | t _r | _ | - | 5 0 5 0 | μS |
| Internal Power Dissipation (All Inputs at VSS and All Outputs Open) (Measured at TA = TL) | PINT | _ | _ | 340 | mW |

^{*}Maximum Input Transition Times are \leq 0.1 \times Pulse Width or the specified maximum of 1.0 μ s, whichever is smaller

FIGURE 2 - OUTPUT TEST LOADS

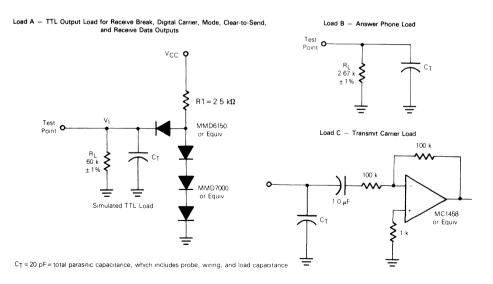
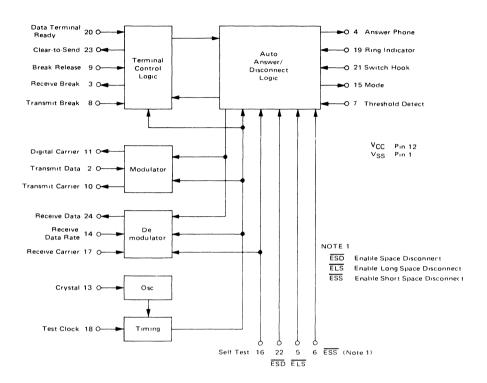


FIGURE 3 — BLOCK DIAGRAM



DEVICE OPERATION*

GENERAL

Figure 1 shows the modem and its interconnections. The data to be transmitted is presented in serial format to the modulator for conversion to FSK signals for transmission on the telephone line (refer to Figure 3). The modulator output is buffered before driving the line

The FSK signal from the remote modem is received via the telephone line and filtered to remove extraneous signals such as the local Transmit Carrier. This filtering can be either a bandpass which passes only the desired band of frequencies or a notch which rejects the known interfering signal. The desired signal is then limited to preserve the axis crossings and fed to the demodulator where the data is recovered from the received FSK carrier.

The Supervisory Control provides the necessary commands and responses for handshaking with the remote modem, along with the interface signals to the data coupler and communication terminal. If the modem is a built-in unit,

*See Tables 1 and 2 for delay time tolerances

all input-output (I/O) logic need not be RS-232 compatible. The use of MC1488 and MC1489A line drivers and receivers will provide a RS-232 interface conforming to the EIA specification.

ANSWER MODE

Automatic answering is first initiated by a receipt of a Ring Indicator ($\overline{R1}$) signal. This can be either a low level for at least 51 ms as would come from a CBS data coupler, or at least 20 cycles of a 20-47 Hz ringing singal (low level \geq 50% of the duty cycle) as would come from a CBT data coupler. The presence of the Ring Indicator signal places the modem in the Answer Mode; if the Data Terminal Ready line is low, indicating the communication terminal is ready to send or receive data, the Answer Phone output goes high. This output is designed to drive a transistor switch which will activate

the Off Hook (OH) and Data Transmission (DA) relays in the data coupler. Upon answering the phone the 2225-Hz Transmit Carrier is turned on

The originate modem at the other end detects this 2225-Hz signal and after a 450 ms delay (used to disable any echo suppressors in the telephone network) transmits a 1270-Hz signal which the local answering modem detects, provided the amplitude and frequency requirements are met. The amplitude threshold is set external to the modem chip. If the signal level is sufficient the $\overline{1D}$ input should be low for 20 μs at least once every 32 ms. The absence of a threshold indication for a period greater than 51 ms denotes the loss of Receive Carrier and the modem begins hang-up procedures. Hang-up will occur 17 s after $\overline{R1}$ has been released provided the handshaking routine is not re-established. The frequenty tolerance during handshaking is \pm 100 Hz from the Mark frequency.

After the 1270-Hz signal has been received for 150 ms, the Receive Data is unclamped from a Mark condition and data can be received. The Clear-to-Send output goes low 450 ms after the receipt of carrier and data presented to the answer modem is transmitted. Refer to Figure 4.

AUTOMATIC DISCONNECT

Upon receipt of a space of 150 ms or greater duration, the modem clamps the Receive Break high. This condition exists until a Break Release command is issued at the receiving station. Upon receipt of a 0.3 s space, with Enable Short Space Disconnect at the most negative voltage (low), the modem automatically hangs up. If Enable Long Space Disconnect is low, the modem requires 1.5 s of continuous space to hang up. Refer to Figure 5.

ORIGINATE MODE

Upon receipt of a Switch Hook (\overline{SH}) command the modem function is placed in the Originate Mode. If the Data Terminal Ready input is enabled (low) the modem will provide a logic high output at Answer Phone. The modem is now ready to receive the 2225-Hz signal from the remote answering modem. It will continue to look for this signal until 17 s after \overline{SH} has been released. Disconnect occurs if the handshaking routine is not established.

Upon receiving 2225 ± 100 Hz for 150 ms at an acceptable amplitude, the receive Data output is unclamped from a Mark condition and data reception can be accomplished 450 ms after receiving a 2225-Hz signal, a 1270-Hz signal is transmitted to the remote modem 750 ms after receiving the 2225-Hz signal, the Clear-to-Send output is taken low and data can now be transmitted as well as received Refer to Figure 6

INITIATE DISCONNECT

In order to command the remote modem to automatically hang up, a disconnect signal is sent by the local modem. This is accomplished by pulsing the normally low Data Terminal Ready into a high state for greater than 34 ms. The local modem then sends a 3 s continuous space and hangs up provided the Enable Space Disconnect is low. If the remote modem hangs up before 3 s, loss of Threshold Detect will cause loss of Clear-to-Send, which marks the line in Answer Mode and turns the carrier off in the Originate Mode.

If ESD is high the modern will transmit data until hang-up occurs 3 s later Receive Break is clamped 150 ms following the Data Terminal Ready interrupt Refer to Figure 7

INPUT/OUTPUT FUNCTIONS

Figure 8 shows the I/O interface for the low speed modem. The following is a description of each individual signal.

Receiver Carrier (Rx Car)

The Receive Carrier is the FSK input to the demodulator The local Transmit Carrier must be balanced or filtered out and the remaining signal hard limited. The conditioned receive carrier is measured by the MC6860. Any half-cycle period greater than or equal to 429 $\pm\,1.0~\mu s$ for the low band or 235 $\pm\,1.0~\mu s$ for the high band is detected as a space Resultant peak phase litter is as follows

| Data Rate Bits per Second | Answer Mode φ _J (Peak %) | Originate Mode φ _J (Peak %) |
|------------------------------|--|---|
| 300 | 7 0 | 3 7 |
| 200 | 4 7 | 2 5 |
| 150 | 3 5 | 18 |
| 110 | 26 | 1 4 |

Ring Indicator (RI)

The modem function will recognize the receipt of a call from the CBT data coupler if at least 20 cycles of the 20-47 Hz ringing singal (low level $\geq 50\%$ of the duty cycle) are present. The CBS data coupler $\overline{\rm RI}$ signal must be level-converted to TTL according to the EIA RS-232 specification before interfacing it with the modem function. The receipt of a call from the CBS data coupler is recognized if the $\overline{\rm RI}$ signal is present for at least 51 ms. This input is held high except during ringing. An $\overline{\rm RI}$ signal automatically places the modem function in the Answer Mode

Switch Hook (SH)

\$\overline{SH}\$ interfaces directly with the CBT data coupler and via the EIA RS-232 level conversion for the CBS data coupler An SH signal automatically places the modern function in the Originate Mode

 \overline{SH} is low during origination of a call. The modem will automatically hang up 17 s after releasing \overline{SH} if the handshaking routine has not been accomplished

Threshold Detect (TD)

This input is derived from an external threshold detector. If the signal level is sufficient, the $\overline{1D}$ input must be low for 20 μs at least once every 32 ms to maintain normal operation. An insufficient signal level indicates the absence of the Receive Carrier, an absence for less than 32 ms will not cause channel establishment to be lost, however, data during this interval will be invalid.

If the signal is present and the level is acceptable at all times, then the threshold input can be low permanently.

Loss of threshold for 51 ms or longer results in a loss of Clear-to-Send. The Transmit Carrier of the originate modem is clamped off and a constant Mark is transmitted from the answer modem

TIMING DIAGRAMS

FIGURE 4 - ANSWER MODE

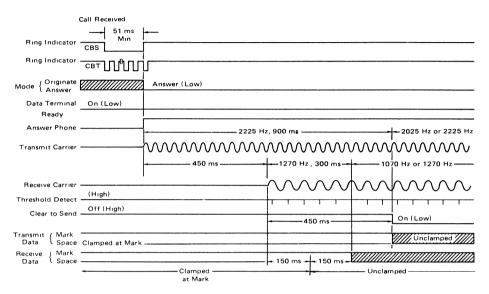


FIGURE 5 - AUTOMATIC DISCONNECT - LONG OR SHORT SPACE

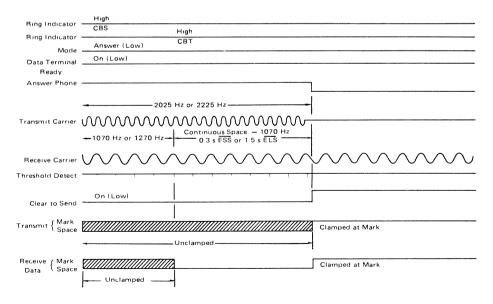


FIGURE 6 - ORIGINATE MODE

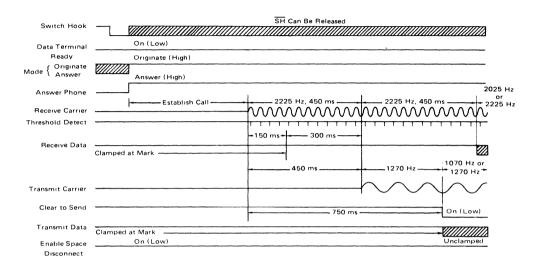
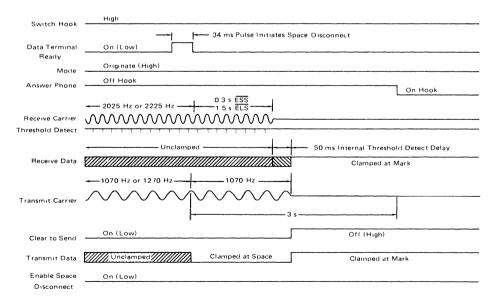


FIGURE 7 - INITIATE DISCONNECT



Receive Data Rate (Rx Rate)

The demodulator has been optimized for signal-to-noise performance at 300 bps and 600 bps. The Receive Data Rate input must be low for 0-600 bps and should be high for 0-300 bps

Transmit Data (Tx Data)

Transmit Data is the binary information presented to the modem function for modulation with FSK techniques. A high level represents a Mark

Data Terminal Ready (DTR)

The Data Terminal Ready signal must be low before the modern function will be enabled. To initiate a disconnect, DTR is held high for 34 ms minimum. A disconnect will occur 3 s later.

Break Release (Brk R)

After receiving a 150 ms space signal, the clamped high condition of the Receive Break output can be removed by holding Break Release low for at least $20 \mu s$.

Transmit Break (Tx Brk)

The Break command is used to signal the remote modem to stop sending data

A Transmit Break (low) greater than 34 ms forces the modem to send a continuous space signal for 233 ms Transmit Break must be initiated only after $\overline{\text{CTS}}$ has been established. This is a negative edge sense input. Prior to initiating $\overline{\text{Tx}}$ Brk, this input must be held high for a minimum of 34 ms.

Enabled Space Disconnect (ESD)

When $\overline{\text{ESD}}$ is strapped low and $\overline{\text{DTR}}$ is pulsed to initiate a disconnect, the modern transmits a space for either 3 s or until a loss of threshold is detected, whichever occurs first. If $\overline{\text{ESD}}$ is strapped high, data instead of a space is transmitted A disconnect occurs at the end of 3 s.

Enable Short Space Disconnect (ESS)

ESS is a strapping option which, when low, will automatically hang up the phone upon receipt of a continuous space for 0.3 s ESS and ELS must not be simultaneously strapped low.

Enable Long Space Disconnect (ELS)

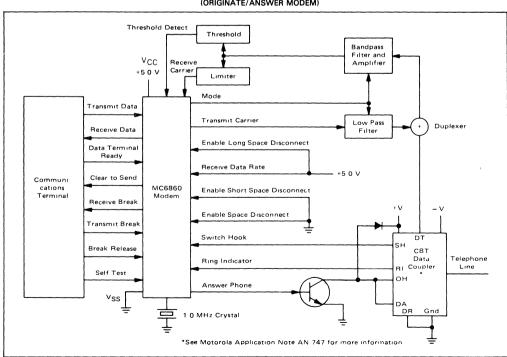
ELS is a strapping option which, when low, will automatically hang up the phone upon receipt of a continuous space for 1.5 s

Crystal (Xtal)

A 1 0 MHz crystal with the following parameters is required to utilize the on-chip oscillator. A 1.0-MHz square wave can also be fed into this input to satisfy the clock requirement.

Mode: Parallel
Frequency 10 MHz ±0 1%
Series Resistance: 70 p F max
Temperature 0-70°C
Test Level 10 mW
Load Capacitance. 13 pF

FIGURE 8 — I/O INTERFACE CONNECTIONS FOR MC6860 (ORIGINATE/ANSWER MODEM)



When utilizing the 1.0 MHz crystal, external parasitic capacitance, including crystal shunt capacitance, must be $\leq 9~\mathrm{pF}$ at the crystal input. Reliable crystal oscillator start-up requires that the VCC power-on transition time be >15 milliseconds.

Test Clock (TST)

A test signal input is provided to decrease the test time of the chip. In normal operation this input *must be strapped* low

Self Test (ST)

When a low voltage level is placed on this input, the demodulator is switched to the modulator frequency and demodulates the transmitted FSK signal. Channel establishement, which occurred during the initial handshake, is not lost during self test. The Mode Control ouput changes state during Self Test, permitting the receive filters to pass the local Transmit Carrier

| ST | SH | RĪ | Mode |
|----|----|----|------|
| Н | 7. | Η | H |
| Н | н | L | L |
| L | ~~ | Н | L |
| L | н | L | Н |

^{*}Note maximum SH low time in Table 1

Answer Phone (An Ph)

Upon receipt of Ring Indicator or Switch Hook signal and Data Terminal Ready, the Answer Phone output goes high $[(\overline{SH}+\overline{RI})*\overline{DTR}]$. This signal drives the base of a transistor which activates the Off Hook, and Data Transmission control lines in the data coupler Upon call completion, the Answer Phone signal returns to a low level.

Mode

The Mode output indicates the Answer (low) or Originate (high) status of the modem. This output changes state when a Self Test command is applied.

Clear-To-Send (CTS)

A low on the $\overline{\text{CTS}}$ output indicates the Transmit Data input has been unclamped from a steady Mark, thus allowing data transmission.

Receive Data (Rx Data)

The Receive Data output is the data resulting from demodulating the Receive Carrier A Mark is a high level

Receive Break (Rx Brk)

Upon receipt of a continuous 150 ms space, the modem automatically clamps the Receive Break output high. This output is also clamped high until Clear-to-Send is established.

Digital Carrier (FO)

A test signal output is provided to decrease the chip test time. The signal is a square wave at the transmit frequency.

Transmit Carrier (Tx Car)

The Transmit Carrier is a digitally-synthesized sine wave (Figure 9) derived from the 1 0 MHz crystal reference. The frequency characteristics are as follows:

| Mode | Data | Transmit Frequency | Tolerance* |
|-----------|-------|-----------------------|------------|
| Originate | Mark | 1270 Hz | – 0 15 Hz |
| Originate | Space | 1070 Hz | 0 90 Hz |
| Answer | Mark | 2225 Hz | -031 Hz |
| Answer | Space | 2025 Hz | - 0 71 Hz |

*The reference frequency tolerance is not included

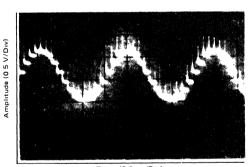
The proper output frequency is transmitted within 3.0 μ s following a data bit change with no more than 2.0 μ s phase discontinuity. The typical output level is 0.35 V (RMS) into 100 k ohm load impedance.

The second harmonic is typically 32 dB below the fundamental (see Figure 10).

POWER-ON RESET

Power-on reset is provided on-chip to insure that when power is first applied the Answer Phone output is in the low (inactive) state. This holds the moder in the inactive or idle mode until a \overline{SH} or \overline{RI} signal has been applied. Once power has been applied, a momentary loss of power at a later time may not be of sufficient time to guarantee a chip reset through the power-on reset circuit

To insure initial power-on reset action, the external parasitic capacitance on \overline{RI} and \overline{SH} should be <30 pF Capacitance values >30 pF may require the use of an external pullup resistor to VCC on these inputs in addition to the pullup devices already provided on chip



Time (0.2 ms/Div)

FIGURE 9 - TRANSMIT CARRIER SINE WAVE

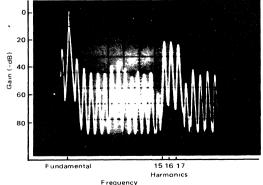


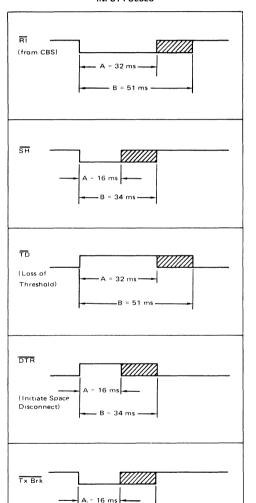
FIGURE 10 — TRANSMIT CARRIER FREQUENCY SPECTRUM

TABLE 1 - ASYNCHRONOUS INPUT PULSE WIDTH AND OUTPUT DELAY VARIATIONS (Time delays specified do not include the 1-MHz reference tolerance)

Due to the asynchronous nature of the input signals with respect to the circuit internal clock, a delay variation or input pulse width requirement will exist. Time delay A is the maximum time for which no response will occur. Time delay B is the minimum time required to guarantee an input response. Input signal widths in the cross hatched region (i.e., greater than A but less than B) may or may not be recognized as valid

For output delays, time A is the minimum delay before an output will respond. Time B is the maximum delay for an output to respond. Output signal response may or may not occur in the cross-hatched region (i.e., greater than A but less than B)

INPUT PULSES



B = 34 ms

*Digital Representation

OUTPUT DELAYS

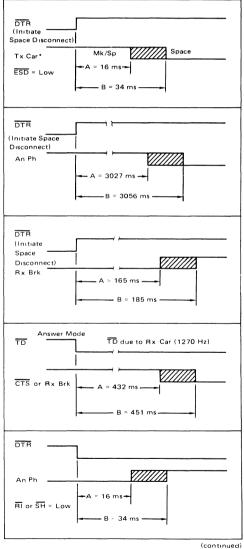
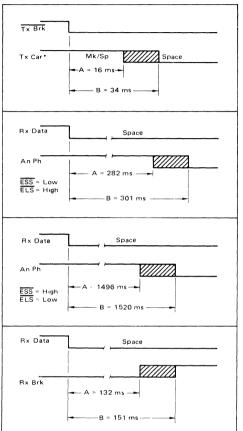


TABLE 1 - OUTPUT DELAY VARIATIONS (continued)



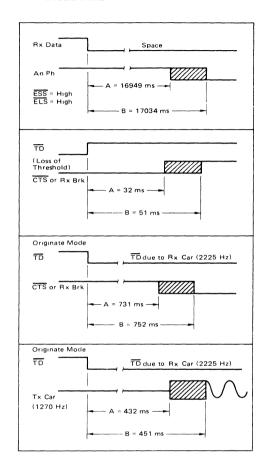


TABLE 2 - TRANSMIT BREAK AND DISCONNECT DELAYS

| Function Description | Min | Max | Unit |
|---|-------|-------|------|
| Tx Brk (Space Duration) | 232 | 235 | ms |
| Space Disconnect (Space Duration) (DTR = High, ESD and TD = Low) | 3010 | 3023 | ms |
| Loss of Carrier Disconnect (Measured from positive edge of \overline{CTS} to negative edge of An Ph, with $\overline{R1}$, \overline{SH} , and \overline{TD} = High) | 16965 | 17034 | ms |
| Override Disconnect (Measured from positive edge of $\overline{R1}$ or \overline{SH} to negative edge of An Ph, with \overline{TD} = High) | 16916 | 17101 | ms |

^{*}Digital Representation

FIGURE 11 - FLOW DIAGRAM

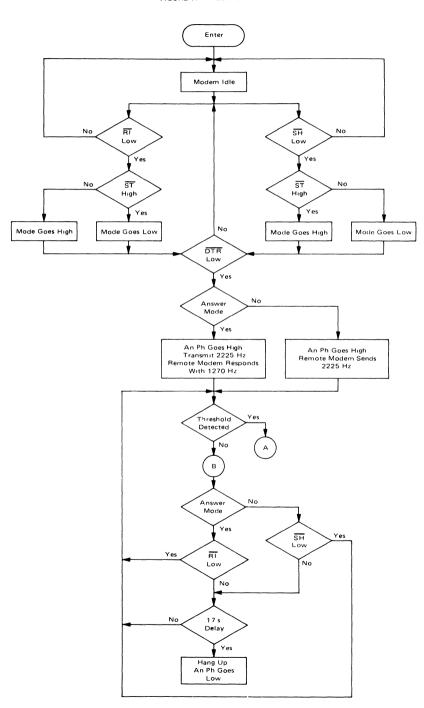
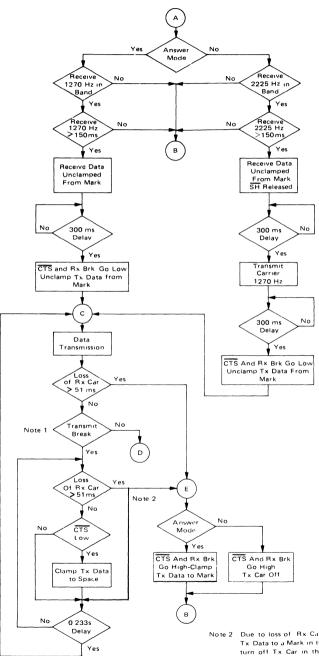


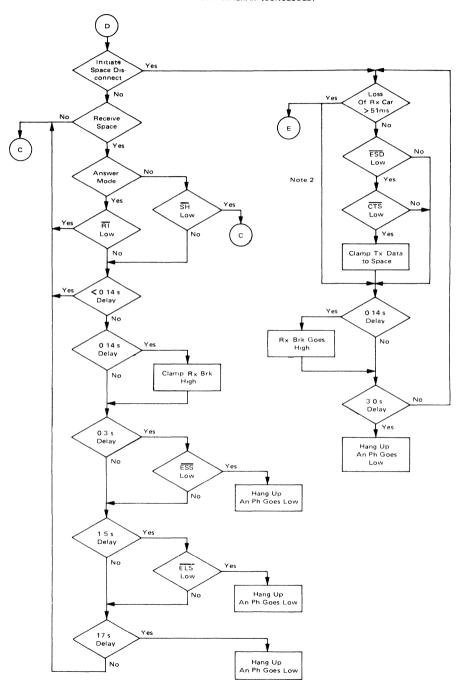
FIGURE 11 - FLOW DIAGRAM (CONTINUED)



Note 1 Transmit Break, Initiate Space Disconnect, and Receive Space are mutually exclusive events

Due to loss of Rx Car, the modem will clamp Tx Data to a Mark in the Answer Mode and will turn off Tx Car in the Originate Mode If Rx Car is detected before completion of Tx Brk or Initiate Space Disconnect, normal operation of Tx Brk or Initiate Space Disconnect will continue until completion of their respective time delays

FIGURE 11 — FLOW DIAGRAM (CONCLUDED)





MC6862

2400 bps DIGITAL MODULATOR

The MC6862 is a MOS subsystem designed to be integrated into a wide range of equipment utilizing serial data communication.

The modulator provides the necessary modulation and control functions to implement a serial data communication link over a voice grade channel, utilizing differential phase shift keying (DKSP) at bit rates of 1200 or 2400 bps. Phase options are provided for both the U S. and international markets. The MC6862 can be implemented into a wide range of data handling systems, including stand-alone modems, data storage devices, remote data communication terminals, and I/O interfaces for counters.

N-channel silicon-gate technology permits the MC6862 to operate using a single voltage supply and be fully TTL compatible

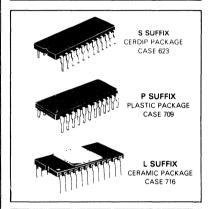
The modulator is compatible with the M6800 microcomputer family, and provides medium-speed data communications capability

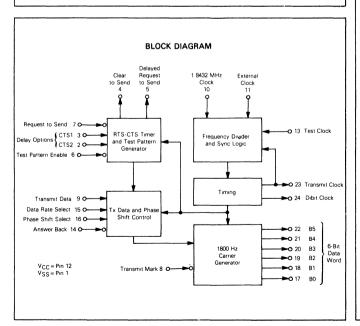
- Clear-to-Send Delay Options
- 511-Bit CCITT Test Pattern
- Terminal Interfaces are TTL Compatible
- Compatible Functions for 201B/C Data Sets
- CCITT and U S Phase Options
- 1200/2400 bps Operation
- Answer-Back Tone

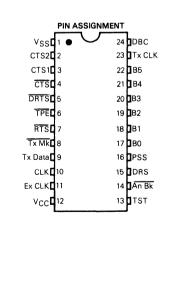
MOS

(N-CHANNEL, SILICON-GATE)

2400 bps MODULATOR







MAXIMUM RATINGS

| Rating | Symbol | Value | Unit |
|---|------------------|--|------|
| Supply Voltage | Vcc | -0.3 to $+7.0$ | ٧ |
| Input Voltage | V _{in} | -03 to +70 | ٧ |
| Operating Temperature Range MC6862 MC6862S, MC6862C | TA | T _L to T _H 0 to 70 - 40 to +85 | °C |
| Storage Temperature Range | T _{stq} | -55 to +150 | °C |

THERMAL CHARACTERISTICS

| 11/21/11/1/12 07/7/11/7/07/27/11/07/100 | | | |
|---|--------|-------|-------|
| Characteristic | Symbol | Value | Unit |
| Thermal Resistance | | | 1 |
| Ceramic Package | | 60 | 10000 |
| Plastic Package | θJA | 120 | °C/W |
| Cerdip Package | | 65 | 1 |
| oc. a.p . ac.tago | 1 1 | | - 1 |

This device contains circuitry to protect the inputs against damage due to high static voltages or electric fields however, it is advised that rior mal precautions be taken to avoid application of any voltage higher than maximum rated voltages to this high-impedance circuit. Reliability of operation is enhanced if unused inputs are tied to an appropriate logic voltage level (e.g., either VSS or VCC)

(1)

POWER CONSIDERATIONS

The average chip-junction temperature, T.j., in °C can be obtained from:

$$T_J = T_A + (P_D \bullet \theta_{JA})$$

Where:

T_A = Ambient Temperature, °C

 $\theta_{JA} \equiv Package Thermal Resistance, Junction-to-Ambient, °C/W$

PD = PINT + PPORT

PINT≡ICC×VCC, Watts - Chip Internal Power

PPORT≡Port Power Dissipation, Watts - User Determined

For most applications PPORT ◀PINT and can be neglected PPORT may become significant if the device is configured to drive Darlington bases or sink LED loads

An approximate relationship between PD and TJ (if PPORT is neglected) is

$$P_D = K - (T_J + 273 ^{\circ}C)$$

(2)

Solving equations 1 and 2 for K gives:

 $K = P_D \bullet (T_A + 273 \circ C) + \theta_{JA} \bullet P_D^2$ Where K is a constant pertaining to the particular part. K can be determined from equation 3 by measuring PD (at equilibrium)

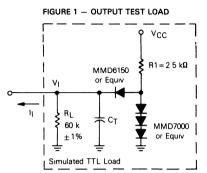
for a known TA. Using this value of K the values of PD and TJ can be obtained by solving equations (1) and (2) iteratively for any value of TA

DC ELECTRICAL CHARACTERISTICS

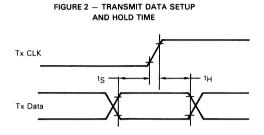
 $(V_{CC} = 5.0 \pm 0.25 \text{ Vdc}, V_{SS} = 0, T_A = T_L \text{ to } T_H$, all outputs loaded as shown in Figure 1 unless otherwise noted)

| Characteristic | Symbol | Min | Тур | Max | Unit |
|---|---------------------------------|---|-----|---------------------|------|
| Input High Voltage | VIH | V _{SS} +20 | _ | Vcc | ٧ |
| Input Low Voltage | V _{IL} | V _{SS} | _ | V _{SS} +08 | V |
| Input Current $(V_{IN} = V_{SS})$ CTS1, CTS2, PSS, DRS, \overline{AnBk} , and \overline{TxMK} \overline{RTS} and \overline{TPE} | l _{in} | | 1 1 | -02 -16 | mA |
| Input Leakage Current (V _{In} = 5 25 V, V _{CC} = V _{SS}) | l)L | _ | - | 25 | μΑ |
| Output High Voltage (I _{OH} = -0 04 mA, Load A) (I _{OH} = 0 0 mA, Load B) | VOH1 VOH2 | V _{SS} +24 V _{CC} -05V | - | Vcc Vcc | ٧ |
| Output Low Voltage (IOL=16 mA, Load A) | VOL | VSS | - | V _{SS} +04 | V |
| Input Capacitance (f=0 1 MHz, T _A =25°C) | C _{in} | _ | 50 | - | pF |
| Internal Power Dissipation (Measured at TA = TL) (All inputs at VSS except Pin 13=57 6 kHz and ALL outputs open) | PINT | _ | 210 | 315 | mW |
| Input Transition Times, All Inputs Except 1 8432 MHz Input (From 10% to 90% points) | t _r , t _f | _ | - | 1 0° | μS |
| Input Transition Times, 1.8432 MHz Input (From 0 8 V to 2 0 V) | t _r , t _f | - | _ | 40 | ns |
| Input Clock Duty Cycle, 1 8432 MHz Input (Measured at 1 5 V level) | DC | 30 | _ | 70 | % |
| Tx Data Setup Time (Figure 2) | ts | 35 | _ | - | μS |
| Tx Data Hold Time (Figure 2) | ^t H | 35 | - | - | μS |
| Output Transition Times | t _r , t _f | _ | _ | 50 | μS |

^{*}Maximum Input Transition Times are ≤0.1 × Pulse Width or the specified maximum of 1.0 µs, whichever is smaller

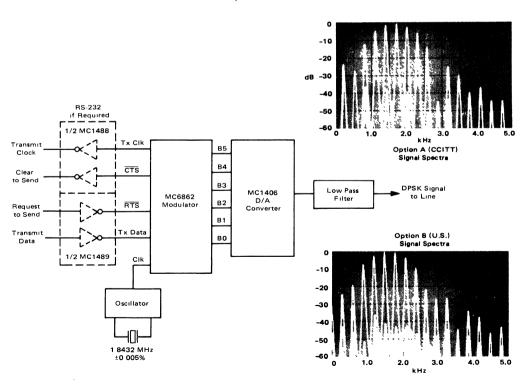


 C_T = 20 pF = total parasitic capacitance, which includes probe, wiring, and load capacitances



Note Timing measurements are referenced to and from a low voltage of 0.8 volts and a high voltage of 2.0 volts, unless otherwise noted

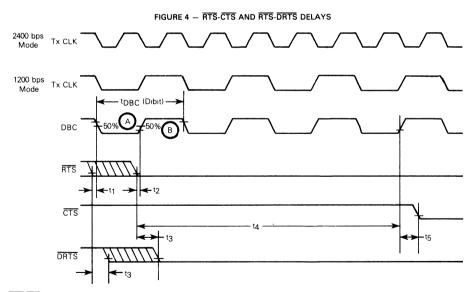
FIGURE 3 - 2400 bps MODULATOR INTERFACE



DELAY TIMINGS (See Figures 4 and 5)

| Characteristic | Symbol | Min | Тур | Max | Unit |
|---|----------------|----------------------------|-------------|-----------------------------|----------------------|
| RTS to DBC Delay | t ₁ | - | - | 8 | μS |
| DBC to RTS Delay | t ₂ | 45 | _ | _ | μS |
| RTS-DRTS Delay | tg | _ | _ | 35 | μS |
| RTS-CTS Delay CTS1=0, CTS2=1 CTS1=1, CTS2=0 CTS1=1, CTS2=1 CTS1=0, CTS2=0 | t4* | 0 8 55 24 9 147 0 | - - - | 35 9 35 26 4 154 0 | μs ms ms ms |
| CTS-DBC Delay CTS1=1, CTS2=0 CTS1=1, CTS2=1 CTS1=0, CTS2=0 | t ₅ | _ _ _ | - - - | 35 35 35 | μS |
| RTS to CTS Low | t ₆ | - | _ | 1 60 | ms |
| RTS Min Delay | t ₇ | _ | | 1 67 | ms |
| DBC to DRTS Delay | t8 | - | _ | 35 | μS |
| DBC Cycle Time | tDBC | 833 28 | 833 33 | 833 37 | μS |

^{*}The reference frequency tolerance is not included



 $\overline{\text{RTS}}\text{-}\overline{\text{CTS}}$ delay options are selected by the CTS1 and CTS2 inputs, and are stated as time delay interval tq. An $\overline{\text{RTS}}$ input signal synchronized about point A will synchronize $\overline{\text{CTS}}$ with the positive transition of DBC (Dibit Clock). Delay tq is measured with respect to the negative transition of $\overline{\text{RTS}}$

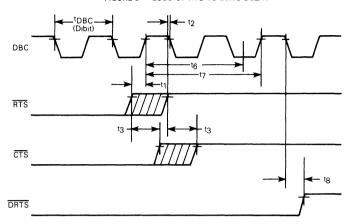
 $\overline{\text{RTS}}$ signals synchronized with the positive transition of DBC (point B), will result in the same $\overline{\text{CTS}}$ delay (t₄). For this case the negative transition of $\overline{\text{CTS}}$ is synchronized with the negative transition of DBC with delay t₄ measured with respect to the negative transition of $\overline{\text{RTS}}$.

 $\overline{\text{DRTS}}$ will go low within t3 of the negative transition of $\overline{\text{RTS}}$. With the exception of the no-delay option, $\overline{\text{CTS}}$ will go low within t5 of the positive transition of DBC, following the t4 delay selected. This applies when $\overline{\text{RTS}}$ is synchronized to Point A as shown

If RTS goes high and remains high \geq 20 μ s within time interval t4, a reset of the internal RTS-CTS timer function will occur if RTS goes high for less than 20 μ s, the circuit may or may not respond to this momentary loss of the RTS signal

Note Timing measurements are referenced to and from a low voltage of 0.8 volts and a high voltage of 2.0 volts, unless otherwise noted

FIGURE 5 - LOSS OF RTS TO DRTS DELAY



A positive transition of RTS after CTS has become active can result in different functional characteristics of the CTS and DRTS output signals, depending on the time duration that RTS remains inactive

Under all conditions, CTS will go high within to following a positive transition of RTS if RTS goes high in the shaded region shown (i.e., synchronized to the positive transition of DBC) and remains high beyond the time interval defined as ty, then DRTS will

go high within to of the next negative transition of DBC If \overline{RTS} were to go low after to, the \overline{RTS} - \overline{CTS} delay times given in Figure 4 will result

If RTS goes high in the shaded region shown, and then returns low within time interval is, the negative transition of CTS will follow within 35 µs, and DRTS will remain in the active or low state. Under these conditions, the normal RTS-CTS delay times are not encountered when RTS is reactivated. If RTS goes low for less than 20 µs, the circuit may or may not respond.

NOTE Timing measurements are referenced to and from a low voltage of 0.8 volts and a high voltage of 2.0 volts, unless otherwise noted

DEVICE OPERATION

GENERAL

Figure 3 shows the modulator and its intra-connections. The data to be transmitted is presented in synchronous serial format to the modulator for conversion to DPSK signals used in transmission. The modulator output is digital, therefore, a D/A converter and a filter transform the signal to an analog form

The control functions provide four different Clear-to-Send delay options An Answer-Back tone is available for automatic answering applications. The modulator has a built-in 511-bit pseudorandom pattern generator for use in system diagnostic tests.

INPUT/OUTPUT FUNCTIONS

Request to Send (RTS)

The $\overline{\text{RTS}}$ signal from the data terminal controls transmission from the modulator. A low level on $\overline{\text{RTS}}$ activates the modulator data output A constant mark, for synchronization, is sent during the $\overline{\text{RTS}}$ to $\overline{\text{CTS}}$ delay interval. Termination of the transmission is accomplished by taking $\overline{\text{RTS}}$ high (see Figures 4 and 5).

Delayed Request to Send (DRTS)

This output can be used to control transmission as specified by the Transmit Mark control input DRTS follows

the negative transition of \overline{RTS} , and goes negative within tg of the negative transition of \overline{RTS} (Figure 4). The delay from a positive transition of \overline{RTS} to a positive transition of \overline{DRTS} is shown in Figure 5. The \overline{DRTS} delay allows data within the modulator to be transmitted before transmission is inhibited

Clear to Send (CTS)

 $\overline{\text{CTS}}$ follows $\overline{\text{RTS}}$ to both the logic 0 and logic 1 levels. The delay from a negative transition of $\overline{\text{RTS}}$ to a negative $\overline{\text{CTS}}$ transition is selectable by external strapping of CTS1 and CTS2. The delay from a positive transition of $\overline{\text{RTS}}$ to a positive $\overline{\text{CTS}}$ transition is less than t4.

CTS will go low within t5 after the positive transition of the Dibit Clock (see Figure 4) except when the non-delay option is selected. For the no-delay option, CTS follows RTS within t5.

RTS-CTS Delay Options (CTS1, CTS2)

The $\overline{\rm RTS}\text{-}\overline{\rm CTS}$ delays are selectable according to the following strapping options

| RTS-CTS Delay | CTS1 | CTS2 |
|-----------------------|------|------|
| 0 0+0 035 ms, -0 0 ms | 0 | 1 |
| 8 55 to 9 35 ms | 1 | 0 |
| 24 90 to 26 4 ms | 1 | 1 |
| 147 0 to 154 0 ms | 0 | 0 |

Transmit Mark (Tx Mk)

The Transmit Mark control allows the system designer to select whether the Delayed Request to Send activitates and deactivates the transmission on the modulator chip or off the chip in the output amplifier.

When Tx Mk is high, transmission is controlled on the modulator chip, and occurs from the chip only when DRTS or Answer Back is in the logic 0 state (see Figure 6)

When Tx Mk is low, transmission is controlled off the modulator chip. In this mode, the modulator chip transmits marks at all times except when data or an Answer-Back tone is being transmitted (see Figure 6).

Test Pattern Enable (TPE)

A 511-bit test pattern generator is contained on the modulator chip This pattern is in accord with CCITT specification V52.

The 511-bit test pattern is activated by applying a logic 0 to TPE. A mark (logic 1) condition on the Transmit Data input with TPE activated (logic 0) causes the test pattern to appear at the data output. A space (logic 0) condition on Tx Data with TPE activated causes the test pattern data to appear inverted at the data output.

Although the Motorola 2400 bps modulator contains a CCITT 511 test pattern generator it does not incorporate the 511 data randomizer or scrambler.

Random data applied to Tx data with TPE activated causes the test pattern data to be scrambled (exclusive NORed) with the data, and the result appears at the data output

The MC6863 demodulator does contain a built-in data descrambler, which is enabled by TPE input going active. To scramble data using the modulator, the circuit in Figure 7 must precede the TX Data input of the modulator. Tx Data is added to the scrambler output pattern. Then the data is delayed by a full data bit before being transmitted by the modem. This assures a proper Transmit Data/Transmit Clock phase relationship.

If the data scrambler is to be an optional feature, then the transmit data multiplexer would also have to be built. This is

selected by the Test Pattern Enable signal or any other signal that is found suitable

The scrambling of data in the data comm environment is not done in an attempt to encrypt information in the normal sense of the word. Rather, the purpose of the scrambling of data is to guarantee that with respect to the modem carrier, there is always random data on the line with little chance for a long string of ones or zeros to exist. This is particularly important if an adaptive equalizer is being incorporated at the demodulator. The adaptive equalizer will require reasonably evenly distributed data to optimize its statistical response to the incoming signal. The normally used code is the CCITT 511 sequence which is EXOR'd with data.

The test pattern generator can be enabled only when $\overline{\text{CTS}}$ and $\overline{\text{RTS}}$ are logic 0. If $\overline{\text{TPE}}$ is activated outside this time interval, the previously stated $\overline{\text{RTS}}$ - $\overline{\text{CTS}}$ and $\overline{\text{RTS}}$ - $\overline{\text{DRTS}}$ delays, shown in Figures 4 and 5, are not valid

Data-Rate Select (DRS)

The modulator can transmit at either 2400 bps or 1200 bps Both data rates utilize an 1800 Hz carrier signal and employ phase shifting at 1200 Hz. The 2400 bps rate is obtained by encoding two bits of data into each phase shift. The 2400 Hz rate is selected by applying a logic 1 to the Data-Rate Select lead. The 1200 Hz rate is selected by applying a logic 0 to DRS.

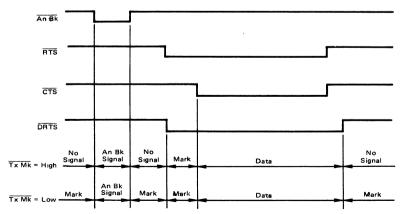
Phase-Shift Select (PSS)

Option A (CCITT) or Option B (U S) phase shift can be selected for 2400 bps operation. The input data format and phase shift relationship for these two options are as follows:

| Data | PSS=0 Option A* | PSS = 1 Option B |
|------|--------------------|---------------------|
| 00 | 0° | + 45° |
| 01 | +90° | + 135° |
| 11 | + 180° | + 225° |
| 10 | + 270° | + 315° |

*See example Figure 8

FIGURE 6 - TRANSMIT MARK CONTROL



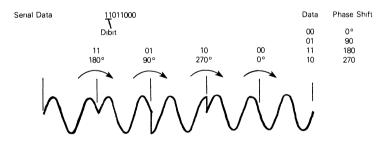
Tx CLK

Tx Data

To Pin 9 Modulator

FIGURE 7 - MODULATOR CCITT 511 DATA SCRAMBLER

FIGURE 8 - EXAMPLE-CARRIER PHASE SHIFTS FOR OPTION A



For 1200 bps operation, Option C (CCITT) or Option D (U S) phase shift can be selected

| Data | PSS = 0 Option C | PSS = 1 Option D |
|------|---------------------|---------------------|
| 0 | +90° | + 45° |
| 1 | + 270° | + 225° |

Option C is selected by applying a logic 0 to the Phase Shift Select lead when the Data Rate Select lead is strapped for 1200 bps operation (logic 0). Option D is selected by applying a logic 1 to PSS with DRS at logic 0. The phase shifts shown are the difference in phase between the signal at the end of one dibit period and the new signal at the beginning of the next dibit.

Transmit Data (Tx Data)

Transmit Data is the serial binary information presented for DPSK modulation. A high level represents a mark. For timing, see Transmit Clock (Figure 4).

Transmit Clock (Tx CLK)

A 2400/1200 Hz Transmit Clock output is provided for the communication terminal. The Transmit Data signal is sampled on the positive transition of Transmit Clock. The Transmit Data to Transmit Clock setup and hold time requirements are shown in the Electrical Characteristics Table and in Figure 2.

Dibit Clock (DBC)

A 1200 Hz Dibit Clock identifies the modulation tirning This signal goes negative less than 100 μs prior to the start of dibit modulation

External Clock (Ex CLK)

A 2400/1200 Hz clock signal applied to the External Clock lead causes Transmit Clock to be synchronized with Ex CLK This input must have an accuracy within $\pm\,0.005\%$

When no transitions occur on this input, the internal clock provides the 2400/1200 Hz transmit timing signal. Fast synchronization of Tx CLK to Ex CLK is not provided on the chip. When Ex CLK is not used, it should be tied to either the logic 0 or logic 1 state.

1.8432 MHz (CLK)

This input must be a square wave with rise and fall times of less than 40 ns and a 50 $\pm20\%$ duty cycle. The clock accuracy must be written $\pm0.005\%$

Answer Back (An Bk)

A logic 0 level applied to Answer Back causes a 2025 Hz carrier to be generated on the modulator chip instead of a phase shifted 1800 Hz carrier A logic 1 level applied to An Bk enables the modulator to generate the normal phase shifted 1800 Hz carrier signal, as shown in Figure 6. The time delay

from a transition on $\overline{\text{An Bk}}$ to the appropriate signal at the modulator chip output is less than 2 ms

Activation of $\overline{An~Bk}$ (a logic 0) will disable all other operation modes including the \overline{Tx} Mk function, and will reset \overline{CTS} to an inactive state along with the \overline{RTX} - \overline{CTS} internal timer $\overline{An~Bk}$ should therefore be activated only before initiating \overline{RTS} or after loss of the \overline{DRTS} output signal. The combination of a logic 0 on $\overline{An~Bk}$ with a logic 0 on \overline{TPE} is not used in normal system operation, and hence is used as a reset input during device test.

Digital Output (B0-B5)

These outputs are designed to interface with a 6-bit digital-to-analog converter. The resultant signal out of the D/A is the differential phase shift keyed signal quantized at a 14.4 kHz rate. A low-pass filter can then be used to smooth the data transitions. B0 is the least-significant bit, and the positive level the active state.

Test Clock (TST)

A test signal input is provided to decrease test time of the chip. In normal operation this input must be strapped low



MC6870, MC6871 series

actual size

Two-Phase Microprocessor Clocks Designed to drive the Motorola MC6800 MPU

The Functional Module approach to data communications hardware design significantly decreases the time between the "idea" stage and the marketable product.

A fundamental building block in a modular microcomputer system is the 2-phase clock oscillator used to drive the microprocessor Motorola is uniquely qualified to provide this building block because of expertise in the three relevant fields oscillator design, quartz crystal technology, and thick film hybrid integrated circuit manufacturing. This one-of-a-kind expertise has created several clocks designed to

Inis one-or-a-kind expertise has created several clocks designed to drive Motorola's MC6800 Microprocessor. This plug-in unit contains the crystal, the oscillator circuit, the NMOS and TTL drivers, and the waveshaping and interface circuitry, all the components necessary to provide the critical non-overlapping 2-phase waveforms used by the MC6800 MPU

FEATURES

Clock Module — Each clock module requires only a single 5 volt power supply The NMOS outputs can drive highly capacitive loads ranging from 80 pf to 160 pf and meet all MPU input waveshape and timing requirements

Each TTL output signal leads the ϕ_2 NMOS so that additional system device delays can be accommodated All TTL outputs are buffered so they can drive 5 TTL devices and maintain all output specifications. Each module is crystal-controlled and is compensated for variations in temperature, voltage, and load. The standard frequency of each model is 1 MHz; however, other frequencies between 250 kHz and 2 5 MHz can be ordered.

Reliability—Decreased Component Count—Thick film hybrids offer a reliability advantage that comes primarily from reduced component count and therefore reduced interconnections. Further, the single hermetic seal on the hybrid package reduces the failure rate whereas in a discrete design a separate sealing process with an associated failure rate is needed for each component.

<code>High Density Packaging</code> —The hybrid MPU clock allows compact microcomputer design. It takes up only 1 34"x .840" space and has a seated height of 200"

Ruggedized Design — Maximum reliability at minimum cost is the result of combining three of Motorola's fields of experience, quartz crystal technology, clock oscillator design, and thick film hybrid integrated circuit manufacturing. Mass automated production techniques assure volume production. Gold plating of all crystals and Class 100 clean room processing testify that no short cuts are taken that might diminish reliability Environmental testing proves the effectiveness of the rugged design for those applications in which shock and vibration are likely hazards

Complete Process Control — Motorola is the only totally integrated manufacturer of quartz frequency control devices; full control of all processes from growing, sawing, lapping, and finishing quartz to combining it with other components into an electronic product — the MC6870A, MC6871A, and MC6871B MPU clocks.

Volume Production — Production facilities are oriented to mass automated production techniques. And, if required, capital for expansion is available to meet even greater requirements.

environmental specifications

Temperature Cycle: ±5 ppm max, 0 to 120°C, 3 cycles, 2 hrs max each, 25 ±2°C ref

Shock: 1000G's 0.35 millisec, ½ sine wave, 3 shocks each plane

Vibration: 10-55 Hz, 060" D A, 55-2000Hz, 35 G's Duration Time—12 Hours Humidity: 85% Rel Humidity, @ +85°C, 250 Hours

mechanical specifications

Gross Leak Test: All units 100% leak tested in de-ionized H₂O

Hermetic Sealed Package: Mass spectrometer leak rate less than 2 x 10 ⁸ atmos cc/sec of helium

Seal Strengh: 20 lbs max force perpendicular to top and bottom

Pin Material: Phosphor bronze, ¼ hard, Grade A 00003" thick gold flash finish

Bend Test: Will withstand maximum bend of 90° reference to base for 1 bend Marking Ink: Epoxy, heat cured

Solvent Resistance: Isopropyl Alcohol Tricholoroethane Freon TMC No marking or seal destruction Dipped 1 minute @ +25°C +5°C in solvent

Note (1) Unit can be cleaned by only one type solvent listed

Note (2) Ultrasonic degreaser not to be used unless frequency and vibration of cleaner specified

solderability specifications

Materials:

1 1 Solder 60% tin and 40% lead

1 2 Flux The flux shall be 25 percent by weight of Grade WW rosin and 75 percent by weight of 99 percent isopropyl alcohol

Procedure:

2.1 Solder Bath. The solder bath shall be maintained at 232 ±6°C.

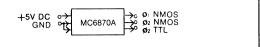
2.2 Solderability Dip the terminals into the flux to the depth that is to be soldered or to a maximum depth of 025" from the body of the oscillator. Keep them in the flux for at least 5 seconds. Withdraw them from the flux. Dip them immediately into the molten solder to the same depth. Keep them in the molten solder for 2 to 5 seconds. Withdraw them and allow the solder to cool in air.

Requirements:

3.1 The terminals are considered solderable and acceptable for electrical connection purposes if 90 percent of the cold solder surface is uniform and free from breaks and pinholes. The other 10 percent of the cooled solder surface may show only pinholes, voids, or rough spots that are not concentrated in one area.

MC6870A

limited function microprocessor clock 250 kHz to 2.5 MHz



specifications

| Rating | Symbol | Value | Unit |
|-----------------------------|-----------------|-------------|------|
| Supply Voltage | Vcc | 5.00±5% | Vdc |
| Operating Temperature Range | T _A | 0 to +70 | °C |
| Storage Temperature | Tstg | -55 to +125 | °C |
| Power Supply Drain (max.) | I _{pd} | 100 | mA |

ELECTRICAL CHARACTERISTICS (V $_{cc}=5.0\,\pm\,5\%,\,V_{tt}=0.T_{\Lambda}=0^{\circ}$ to 70°C, unless otherwise noted)

| Characteristic | Symbol | Min | Тур | Max | Unit |
|--|------------------------------------|--|-----------|--|------------|
| Frequency | | | | | |
| Operating Frequency Frequency stability (inclusive of calibration tolerance at | fc | .250 | ±.01 | 2.5 | MHz % |
| +25°C, operating temperature, input voltage change, load change, aging, shock and vibration) | | | | | |
| NMOS Outputs at 1.0 MHz Oper | ation** | | | | |
| Pulse Width (meas. at $V_{cc} =3V$ dc level) | TØ₁H TØ₂H | 430 450 | | | ns ns |
| Logic Levels | V _{OLC} | V1 V3 | _ | V ₁₁ + 3 V _{cc} + 1 | Vdc Vdc |
| Rise and Fall Times | t _r | 5 5 | 12 12 | 50 50 | ns ns |
| *Overshoot/Undershoot Logic ''1'' Logic ''0'' | Vos | V _{cc} 5 V _{ss} 5 | | Vcc+.5 Vss+.5 | Vdc Vdc |
| Pulse duration of any over- shoot or undershoot | Tos | | | 40 | ns |
| Period @ 0.3V dc Level | t _{cyc} | | 1.00 | | us |
| Edge Timing @ V _{cc} =0.3V dc | Tx | 940 | | | ns |
| NMOS Relationship @ +0.5V dc Level | t _{d1} t _{d2} | 0 | | 8.0 | us |
| TTL Outputs | | | | | |
| In ref. to Ø₂ NMOS @ 0.3V dc | | | | | |
| Ø₂ TTL @ +1.4V dc | T _A T _H | 15 10 | 30 25 | 45 40 | ns ns |
| Logic Levels | V _{OH} V _{OL} | 2.4 | 3.2 .3 | .4 | Vdc Vdc |
| Rise and Fall Times .4V and 2.4V 2.4V and .4V | t _r | | | 15 15 | ns ns |
| Logic "0" Sink (/Gate) | loL | | | -1.6 | mA |
| Logic "1" Source (/Gate) | Іон | | | +40 | uA |
| Current Output Shorted | Isc | -18 | | -57 | mΑ |
| Load | | | | | |
| NMOS-Load Capacity Ø ₁ , Ø ₂ | CNMOS | 80 | 120 | 160 | pf |
| TTL-No. of Loads | | | | 5 | ttl |
| TTL-Load Capacity | Стть | | | 50 | pf |
| *Into specified test load | | | | | |

| Ľ | IL- | | oac | 1 C | ap | ac | ıτy | |
|---|------|------|------|------|------|----|------|---|
| • | Inte | 2 61 | nec. | fied | l te | et | load | 4 |

[&]quot;Apply the following parameters for frequencies other than 1.0 MHz

T\$\phi H=0.5 (P-140) \text{ ins}

T\$\phi H=0.5 (P-100) \text{ ins}

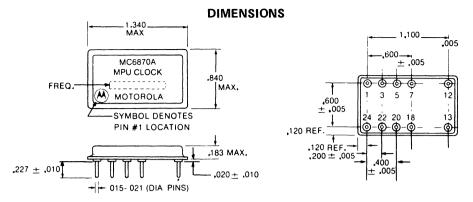
T\$\pmi H=0.5 (P-100) \text{ ins}

where P=desired period of operation in nanoseconds

| 1 GND 3 NC 5 Ø₂TTL 7 V₂ҫ (+5VDC) 12 Ø₂NMOS 13 Ø₁NMOS 18 GND 20 NC 22 NC | PIN | CONNECTION |
|---|-----|---------------------|
| 5 Ø₂ TTL 7 Vcc (+5VDC) 12 Ø₂ NMOS 13 Ø₁ NMOS 18 GND 20 NC 22 NC | 1 | GND |
| 7 V _{cc} (+5VDC) 12 Ø₂ NMOS 13 Ø₁ NMOS 18 GND 20 NC 22 NC | 3 | NC |
| 12 Ø₂ NMOS 13 Ø₁ NMOS 18 GND 20 NC 22 NC | 5 | Ø₂ TTL |
| 13 Ø NMOS 18 GND 20 NC 22 NC | 7 | V₀₀ (+5VDC) |
| 18 GND 20 NC 22 NC | 12 | Ø₂ NMOS |
| 20 NC 22 NC | 13 | Ø _i NMOS |
| 22 NC | 18 | GND |
| | 20 | NC |
| | 22 | NC |
| 24 NC | 24 | NC |

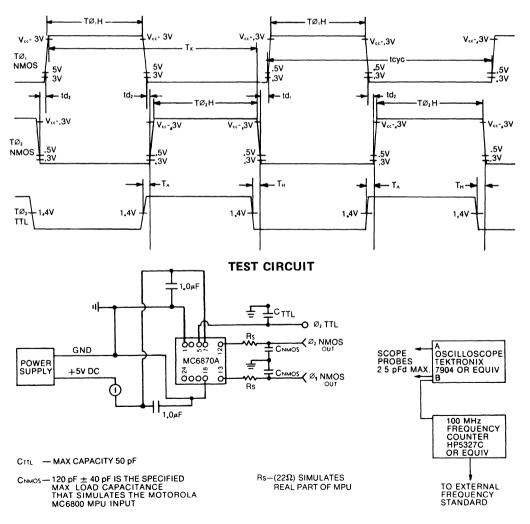
Note All dimensions are in inches

MC6870A (continued)



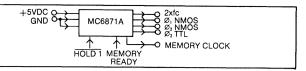
WAVEFORM TIMING

(ALL TIME IN NANOSECONDS)



MC6871A

full function microprocessor clock 850 kHz to 2.5 MHz



specifications

| Rating | Symbol | Value | Unit |
|-----------------------------|-----------------|-------------|------|
| Supply Voltage | Vcc | 5.00±5% | Vdc |
| Operating Temperature Range | TA | 0 to +70 | °C |
| Storage Temperature | Tstg | -55 to +125 | °C |
| Power Supply Drain (max.) | l _{pd} | 100 | mA |

ELECTRICAL CHARACTERISTICS (Vcc = 5.0 \pm 5%, Vii = O,Ta = 0° to 70°C, unless otherwise noted)

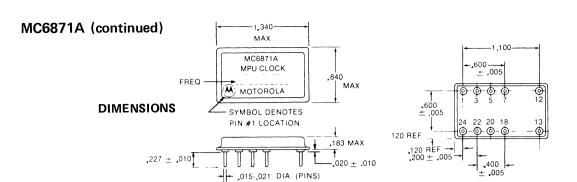
| Characteristic | Symbol | Min | Тур | Max | Unit |
|---|-------------------|---------------------|----------|---------------------|----------|
| Frequency | | | | | |
| Operating Frequency | f _c | 850 | | 25 | MHz |
| Frequency stability (inclusive | | | ± 01 | | % |
| of calibration tolerance at | | | | | |
| +25°C, operating temperature, | | | | İ | |
| input voltage change, load change, aging, shock and | | | | | |
| vibration) | | | | | |
| NMOS Outputs at 1.0 MHz Oper | ation*** | - | | | |
| Pulse Width (meas. at | TØ,H | 430 | | | ns |
| $V_{cc} = -3V dc level$ | TØ₂H | 450 | | | ns |
| Logic Levels | Volc | Vss1 | _ | V ₃₅ +.3 | Vdc |
| | V _{онс} | V _{cc} - 3 | | V _{cc} +.1 | Vdc |
| Rise and Fall Times | t _r | 5 | 12 | 50 | ns |
| •0 | t, | 5 | 12 | 50 | ns |
| *Overshoot/Undershoot Logic ''1'' | | Vcc5 | | V _{cc} + 5 | Vdc |
| Logic "0" | Vos | V _{ss} - 5 | | V ₃ + 5 | Vdc |
| Pulse duration of any over- | - | | | | |
| shoot or undershoot | Tos | | | 40 | ns |
| Period @ 0.3V dc Level | tcyc | | 1 00 | | us |
| Edge Timing @ Vcc=0 3V dc | Tx | 940 | | | ns |
| NMOS Relationship | t _{d1} | 0 | | | |
| @ +0 5V dc Level | t _{d2} | 0 | | 80 | us |
| TTL Outputs | | | | | |
| In ref to Ø₂ NMOS @ 0 3V dc | | | | | |
| Ø ₂ TTL | ŢΛ | 15 | 30 | 45 | ns |
| @ 1 4V dc | Тн | 10 | 25 | 40 | ns |
| Memory Clock | Tc | 30 20 | 50 40 | 70 60 | ns |
| @ 1 4V dc 2xfc @ 1 4V dc | T _J | 40 | 80 | 120 | ns ns |
| 2xic @ 1 4v dc | 18 | 40 | 80 | 120 | 115 |
| Logic Levels | V _{он} | 2 4 | 3 2 | ١, | Vdc |
| Rise and Fall Times | Vol | | .3 | .4 | Vdc |
| .4V and 2.4V | t, | i . | | 15 | ns |
| 2.4V and .4V | t _f | | | 15 | ns |
| Logic "0" Sink (/Gate) | loL | | | -16 | mΑ |
| Logic "1" Source (/Gate) | Іон | | | +40 | uA |
| Current Output Shorted | Isc | 18 | | <u>57</u> | mΑ |
| Load | | | | | } |
| NMOS-Load Capacity Ø1, Ø2 | C _{NMOS} | 80 | 120 | 160 | pf |
| TTL-No. of Loads | | | | 5 | ttl |
| TTL-Load Capacity | Cttl | | | 50 | pf |
| Logic Inputs** ("0" Level Appli | | or ME | MORY | READY |) |
| Holds Ø, NMOS 'High', Ø2 | T | 2 | | + 4 | Vdc |
| NMOS 'Low', Ø₂ TTL 'Low' | HOLD 1 | | | ' ' | - = = |
| Holds Ø, NMOS 'Low', Ø, NMOS | MEM- | - 2 | <u> </u> | + 4 | Vdc |
| 'High', Ø₂ TTL 'High', and | ORY | | | | |
| MEMORY CLOCK 'High' | READY | 1 | l | 1 | 1 |

^{**}Must be externally held at "1" level (2 4V min , 5 0V max) if not used

| PIN | CONNECTION |
|-----|-------------------------|
| 1 | GND |
| 3 | MEMORY CLOCK |
| 5 | Ø₂ TTL |
| 7 | V _{cc} (+5VDC) |
| 12 | Ø₂ NMOS |
| 13 | Ø: NMOS |
| 18 | GND |
| 20 | HOLD 1 |
| 22 | MEMORY READY |
| 24 | 2xfc |

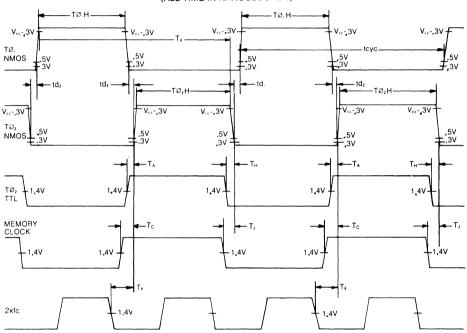
Note: All dimensions are in inches

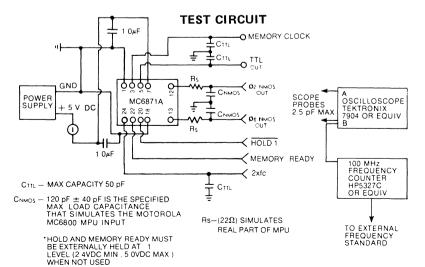
[&]quot;*Apply the following parameters for frequencies other than 1 MHz T₀:H=0.5 (P-140) ns T₂:H=0.5 (P-100) ns T₂:H=0.5 (P-100) ns T₂:H=0.5 (P-100) ns where P=desired period of operation in nanoseconds



WAVEFORM TIMING

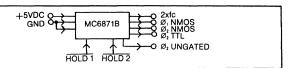
(ALL TIME IN NANOSECONDS)





MC6871B

alternate function microprocessor clock 250 kHz to 2.5 MHz



specifications

| Rating | Symbol | Value | Unit |
|-----------------------------|-----------------|-------------|------|
| Supply Voltage | Vcc | 5.00±5% | Vdc |
| Operating Temperature Range | TA | 0 to +70 | °C |
| Storage Temperature | Tstg | -55 to +125 | °C |
| Power Supply Drain (max) | I _{pd} | 100 | mA |

ELECTRICAL CHARACTERISTICS ($V_{cc} = 5.0 \pm 5\%$, $V_{ss} = 0$, T_A = 0° to 70°C, unless otherwise noted)

| Frequency Operating Frequency Frequency stability (inclusive of calibration tolerance at +25°C, operating temperature, input voltage change, load change, aging, shock and vibration) NMOS Outputs at 1.0 MHz Oper Pulse Width (meas at Vcc — 3V dc level) Logic Levels | ation*** TØ,H TØ2H Voic Vohc t, | 430 450 V ₁₅ - 1 V _{cc} - 3 | ± 01 | 25 V _n + 3 | MHz % |
|--|------------------------------------|--|----------|--|------------|
| Frequency stability (inclusive of calibration tolerance at +25°C, operating temperature, input voltage change, load change, aging, shock and vibration) NMOS Outputs at 1.0 MHz Oper Pulse Width (meas at V., = 3V dc level) Logic Levels | ation*** TØ1H TØ2H Volc Vohc | 430 450 V ₃ -1 V _{cc} -3 | | V ₁₁ + 3 | % |
| Pulse Width (meas at $V_{cc} = -3V$ dc level) Logic Levels | TØ₁H TØ₂H Volc Vohc | 450 V ₃ - 1 V _{cc} - 3 | | | |
| V _{cc} = - 3V dc level) Logic Levels | TØ₂H Volc Vohc t, | 450 V ₃ - 1 V _{cc} - 3 | | | |
| <u> </u> | V _{OHC} | V 3 | | | |
| | 1 . | | 12 | V _{cc} +.1 | Vdc Vdc |
| Rise and Fall Times | | 5 | 12 | 50 50 | ns ns |
| *Overshoot/Undershoot Logic ''1'' Logic ''0'' | Vos | V _{cc} - 5 V _{ss} - 5 | | V _{cc} +.5 V _{ss} +.5 | Vdc Vdc |
| Pulse duration of any over- shoot or undershoot | Tos | | | 40 | ns |
| Period @ 0 3V dc Level | tcyc | | 1 00 | | us |
| Edge Timing @ V _{cc} =0 3V dc | Tx | 940 | | | ns |
| NMOS Relationship @ +0 5V dc | ta. taz | 0 | | 8.0 | us |
| TTL Outputs | | | | | |
| In ref to Ø₂ NMOS @ 0 3V dc | | | | | |
| Ø₂ TTL @ 1 4V dc | T _A T _H | 15 10 | 30 25 | 45 40 | ns ns |
| ⊘₂ Ungated @ 1 4V dc | T _C | 30 20 | 50 40 | 70 60 | ns ns |
| 2xfc @ 1 4V dc | T _B | 40 | 80 | 120 | ns |
| Logic Levels | V _{OH} V _{OL} | 2.4 | 3.2 | .4 | Vdc Vdc |
| Rise and Fall Times .4V and 2.4V 2.4V and 4V | tr tr | | | 15 15 | ns ns |
| Logic "0" Sink (/Gate) | loL | | | -16 | mΑ |
| Logic "1" Source (/Gate) | Іон | | | +40 | uA |
| Current Output Shorted | Isc | —18 | | <u>-57</u> | mA |
| Load | _ | | | | |
| NMOS—Load Capacity Ø₁, Ø₂ | C _{NMOS} | 80 | 120 | 160 | pf |
| TTL-No. of Loads | | | | 5 | ttl |
| TTL-Load Capacity | Cttr | | | 50 | pf |
| Logic Inputs** ("0" Level applie | s HOLD) | | | | |
| Holds Ø ₁ NMOS 'High', Ø ₂ NMOS 'Low', Ø ₂ TTL 'Low' | HOLD 1 | 2 | | +.4 | Vdc |
| Holds Ø, NMOS 'Low', Ø2 NMOS 'High', Ø2 TTL 'High' | HOLD 2 | 2 | | +.4 | Vdc |

| | | | • | |
|--------|----------|-----|-----|------|
| - into | specifie | ס נ | est | load |

^{**}Must be externally held at "1" level (2 4V min , 5 0V max) if not used

| PIN | CONNECTION |
|-----|-------------------------|
| 1 | GND |
| 3 | Ø₁ TTL UNGATED |
| 5 | Ø₂ TTL |
| 7 | V _{εε} (+5VDC) |
| 12 | Ø₂ NMOS |
| 13 | Ø _i NMOS |
| 18 | GND |
| 20 | HOLD 1 |
| 22 | HOLD 2 |
| 24 | 2xfc |

Note 4xfc available on request Note All dimensions are in inches

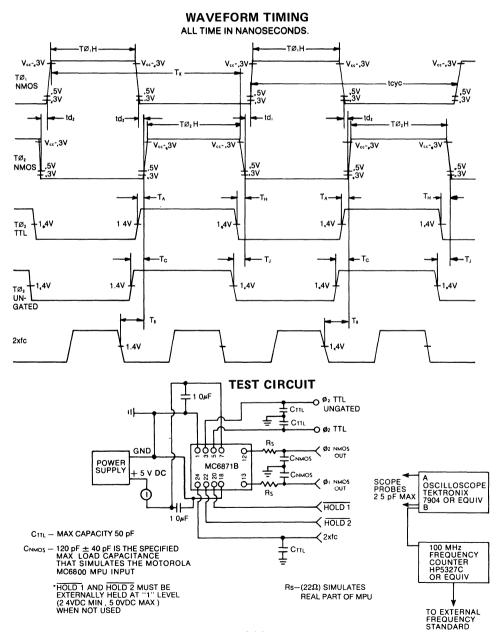
^{***}Apply the following parameters for frequencies other than 1 MHz

Tø:H=0 5 (P-140) ns

Tx=(P-60) ns

where P=desired period of operation in nanoseconds

MC6871 (continued) 1,340-MAX -1,100-MC6871B 600 ± .005 MPU CLOCK .840 FREQ -MAX M MOTOROLA -600 DIMENSIONS ±.005 SYMBOL DENOTES 22 20 18 PIN #1 LOCATION (o-o-o-o ,120 REF .183 MAX .120 REF -.200 ± .005 .227 ± .010 .400 .020 ± .010 ± .005





MC6875 MC6875A

Specifications and Applications Information

M6800 CLOCK GENERATOR

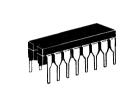
Intended to supply the non-overlapping $\phi 1$ and $\phi 2$ clock signals required by the microprocessor, this clock generator is compatible with 1.0, 1.5, and 2.0 MHz versions of the MC6800. Both the oscillator and high capacitance driver elements are included along with numerous other logic accessory functions for easy system expansion.

Schottky technology is employed for high speed and PNP-buffered inputs are employed for NMOS compatibility. A single +5 V power supply, and a crystal or RC network for frequency determination are required.

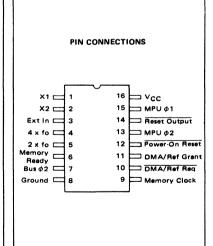
Typical MPU System with Bus Extenders MC6875 CLOCK x fo MPU GND +5 V MC6800 MC6885/MC8T95 MC6880A/MC8T26A thru MC6888/MC8T98 MC6889/MC8T28 **BUS EXTENDER** MC6830 ROMs ADDRESS MC6810 AND CONTROL DATA BUS BUS MC6820 PIAs MC6850 MC6860 MODEM

M6800 TWO-PHASE CLOCK GENERATOR/DRIVER

SCHOTTKY MONOLITHIC INTEGRATED CIRCUIT



L SUFFIX CERAMIC PACKAGE CASE 620



| ORDERING INFORMATION | | | | | | |
|----------------------|-------------------|-------------|--|--|--|--|
| Device | Temperature Range | Package | | | | |
| MC6875L | 0 to +70°C | Ceramic Dip | | | | |
| MC6875AL | -55 to +125°C | Ceramic Dip | | | | |

ABSOLUTE MAXIMUM RATINGS (Unless otherwise noted T_A = 25°C.)

| Rating | Symbol | Value | Unit |
|--|------------------|-------------------------|------|
| Power Supply Voltage | Vcc | +7.0 | Vdc |
| Input Voltage | VI | +5.5 | Vdc |
| Operating Ambient Temperature Range MC6875L MC6875AL | TA | 0 to +70 -55 to +125 | °C |
| Storage Temperature Range Ceramic Package | T _{stg} | -65 to +150 | °С |
| Operating Junction Temperature Ceramic Package | Tj | 175 | °C |

NOTE MC6875AL requires the use of a heat sink See note in Thermal Data.

RECOMMENDED OPERATING CONDITIONS

| Rating | Symbol | Value | Unit |
|-------------------------------------|--------|----------------|------|
| Power Supply Voltage | vcc | +4.75 to +5.25 | Vdc |
| Operating Ambient Temperature Range | TA | 0 to +70 | °c |

ELECTRICAL CHARACTERISTICS

(Unless otherwise noted specifications apply over recommended power supply and temperature ranges. Typical values measured at V_{CC} = 5.0 V and T_A = 25°C.)

| Characteristic | Symbol | Min | Тур | Max | Unit |
|--|-------------------|--------------|-----|-----------------------|------|
| Output Voltage - High Logic State | | | | | |
| MPU ϕ 1 and ϕ 2 Outputs | l | l | | 1 1 | V |
| $(V_{CC} = 4.75 \text{ V}, I_{OHM} = -200 \mu\text{A})$ | Vонм | VCC - 0 6 | | | |
| (V _{CC} = 5.25 V, I _{OHMK} = +5.0 mA) | VOHMK | | | V _{CC} + 1.0 | |
| Bus ϕ 2 Output | | | | | V |
| (V _{CC} = 4.75 V, I _{OHB} = -10 mA) | Vонв | 24 | _ | - | |
| $(V_{CC} = 5.25 \text{ V}, I_{OHBK} = +5.0 \text{ mA})$ | VOHBK | | | V _{CC} + 1.0 | |
| 4 x fo Output | 1 | 1 . 1 | | | V |
| $(V_{CC} = 4.75 \text{ V}, V_{IH} = 2.0 \text{ V}, I_{OH4X} = -500 \mu\text{A})$ | V _{OH4X} | 2.4 | | | |
| 2 x fo, DMA/Refresh Grant and Memory Clock Outputs | Voн | 2.4 | _ | - | V |
| $(V_{CC} = 4.75 \text{ V}, I_{OH} = -500 \mu\text{A})$ | <u> </u> | ļ | | | |
| Reset Output | VOHŘ | 2.4 | - | - | V |
| $(V_{CC} = 4.75 \text{ V}, V_{IH} = 3.3 \text{ V}, I_{OHR} = -100 \mu\text{A})$ | | <u> </u> | | | |
| Output Voltage — Low Logic State | 1 | | | 1 1 | |
| MPU ϕ 1 and ϕ 2 Outputs | | | | | V |
| $(V_{CC} = 4.75 \text{ V}, I_{OLM} = +200 \mu\text{A})$ | VOLM | - | - | 0.4 | |
| $(V_{CC} = 4.75 \text{ V}, I_{OLMK} = -5.0 \text{ mA})$ | VOLMK | - | _ | -10 | |
| Bus ϕ 2 Output | | | | | V |
| $(V_{CC} = 4.75 \text{ V, } I_{OLB} = +48 \text{ mA})$ | VOLB | - | _ | 0.5 | |
| $(V_{CC} = 4.75 \text{ V}, I_{OLBK} = -5.0 \text{ mA})$ | VOLBK | - | | -1.0 | |
| 4 x fo Output | | | | | V |
| $(V_{CC} = 4.75 \text{ V}, V_{IL} = 0.8 \text{ V}, I_{OL4X} = 16 \text{ mA})$ | VOL4X | - | _ | 0.5 | |
| 2 x fo, DMA/Refresh Grant and Memory Clock Outputs | VOL | _ | - | 0.5 | V |
| $(V_{CC} = 4.75 \text{ V, } I_{OL} = 16 \text{ mA})$ | - | | | | |
| Reset Output | VOLR | _ | _ | 0.5 | V |
| $(V_{CC} = 4.75 \text{ V}, V_{IL} = 0.8 \text{ V}, I_{OLR} = 3.2 \text{ mA})$ | | | | | |
| Input Voltage — High Logic State | | | | | V |
| Ext. In, Memory Ready and DMA/Refresh Request Inputs | l v _{iH} | 2.0 | _ | _ | |
| Input Voltage Low Logic State | | | | | V |
| Ext In Memory Ready and DMA/Refresh Request Inputs | VIL | 1 _ 1 | _ | 08 | • |
| Ext III, Wolford Tready and DMA/Horican Hodgest Hiputs | - 'IL | | | 00 | |
| Input Thresholds — Power-On Reset Input (See Figure 2) | 1 | 1 | | 1 | V |
| Output Low to High | VILH | - | 2.8 | 3.6 | |
| Output High to Low | VIHL | 0.8 | 1.4 | - | |
| Input Clamp Voltage MC6875L | Vic | _ | _ | -1.0 | V |
| | *10 | - | _ | -1.5 | • |
| | | <u> </u> | | + | |
| Input Current - High Logic State | | | | | |
| Ext. In, Memory Ready and DMA/Refresh Request Inputs | ЧН | - | _ | 25 | μΑ |
| (V _{CC} = 4.75 V, V _{IH} = 5.0 V) | 1 | | | | |
| Power-On Reset | IHR | - | _ | 50 | μА |
| (V _{CC} = 5.0 V, V _{IHR} = 5.0 V) | | | | | |
| Input Current — Low Logic State | | | | | |
| Ext. In, Memory Ready and DMA/Refresh Request Inputs | l IIL | - | _ | -250 | μΑ |
| $(V_{CC} = 5.25 \text{ V}, V_{IL} = 0.5 \text{ V})$ | | | | 1 1 | |
| Power-On Reset Input | IILR | - | _ | -250 | μА |
| (V _{CC} = 5.25 V, V _{IL} = 0.5 V) | 1 | 1 1 | | 1 1 | |

OPERATING DYNAMIC POWER SUPPLY CURRENT

| Characteristic | Symbol | Min | Тур | Max | Unit |
|--|--------|-----|-----|-----|------|
| Power Supply Currents | | | | | |
| (V _{CC} = 5.25 V, f _{osc} = 8.0 MHz, V _{IL} = 0 V, V _{IH} = 3.0 V) Normal Operation (Memory Ready and DMA/Refresh Request Inputs at High Logic State) | ICCN | - | | 150 | mA |
| Memory Ready Stretch Operation (Memory Ready Input at Low Logic State; DMA/Refresh Request Input at High Logic State) | ICCMR | _ | _ | 135 | mA |
| DMA/Refresh Request Stretch Operation (Memory Ready Input at High Logic State, DMA/Refresh Request Input at Low Logic State) | ICCDR | _ | _ | 135 | mA |

SWITCHING CHARACTERISTICS (These specifications apply whether the Internal Oscillator (see Figure 9) or an External Oscillator is used (see Figure 10) Typical values measured at $V_{CC} = 5.0 \text{ V}$, $T_A = 25^{\circ}\text{C}$, fo = 1.0 MHz (see Figure 8).

| Characteristic | Symbol | Min | Тур | Max | Unit |
|---|----------------|---------|----------|--------------|--|
| MPU φ1 AND φ2 CHARACTERISTICS | | | | | |
| Output Period (Figure 3) | t _o | 500 | - | _ | ns |
| Pulse Width (Figure 3) | t PWM | | | | ns |
| (fo = 1.0 MHz) | | 400 | _ | - | |
| (fo = 1.5 MHz) | | 230 | - | - | |
| (fo = 2.0 MHz) | | 180 | _ | l | |
| Total Up Time (Figure 3) | tupm | | | | ns |
| (fo = 1.0 MHz) | | 900 | _ | _ | 1 |
| (fo = 1.5 MHz) | | 600 | - | - | |
| (fo = 2.0 MHz) | | 440 | - | - | |
| Delay Time Referenced to Output Complement (Figure 3) | | | | | |
| Output High to Low State (Clock Overlap at 1.0 V) | t PLHM | 0 | - | _ | ns |
| Delay Times Referenced to 2 x fo (Figure 4 MPU φ2 only) | | | | | |
| Output Low to High Logic State | tPLHM2X | _ | _ | 85 | ns |
| Output High to Low Logic State | †PHLM2X | _ | _ | 70 | ns |
| Transition Times (Figure 3) | | | | 1 | |
| Output Low to High Logic State | tTLHM | _ | _ | 25 | ns |
| Output High to Low Logic State | tTHLM | _ | _ | 25 | ns |
| BUS ¢2 CHARACTERISTICS | | | L | J | |
| Pulse Width — Low Logic State (Figure 4) | tPWLB | | | 1 | ns |
| (fo = 1.0 MHz) | 1744 | 430 | _ | _ | |
| (fo = 1.5 MHz) | | 280 | | | |
| (fo = 2.0 MHz) | | 210 | _ | _ | |
| Pulse Width — High Logic State | tрwнв | | | | ns |
| (fo = 1.0 MHz) | TOWNS | 450 | _ | _ | |
| (fo = 1.5 MHz) | | 295 | _ | _ | |
| (fo = 2.0 MHz) | | 235 | - | - | |
| Delay Times — (Referenced to MPU φ1) (Figure 4) | | | | | |
| Output Low to High Logic State | tPLHBM1 | | | | ns |
| (fo = 1.0 MHz) | | 480 | - | - | |
| (fo = 1.5 MHz) | | 320 | _ | 1 - | |
| (fo = 2.0 MHz) | | 240 | _ | _ | |
| Output High to Low Logic State | tPHLBM1 | | | | |
| (C _L = 300 pF) | | _ | | 25 | |
| $(C_L = 100 pF)$ | | - | - | 20 | |
| Delay Times (Referenced to MPU φ2) (Figure 4) | 1 | | | | |
| Output Low to High Logic State | tPLHBM2 | -30 | - | +25 | ns |
| Output High to Low Logic State | tPHLBM2 | 0 | _ | +40 | ns |
| Transition Times (Figure 4) | | | <u> </u> | † | |
| Output Low to High Logic State | tTLHB | _ | _ | 20 | ns |
| Output High to Low Logic State | t THLB | l _ | _ | 20 | ns |

SWITCHING CHARACTERISTICS (continued)

| SWITCHING CHARACTERISTICS (continued) | | | T | | |
|---|-------------------|----------|----------|----------|------|
| Characteristic | Symbol | Min | Тур | Max | Unit |
| MEMORY CLOCK CHARACTERISTICS | | | | | |
| Delay Times (Referenced to MPU ϕ 2) (Figure 4) | | | | | |
| Output Low to High Logic State | †PLHCM | -50 | - | +25 | ns |
| Output High to Low Logic State | †PHLCM | 0 | | +40 | ns |
| Delay Times (Referenced to 2 x fo) (Figure 4) | | | | | |
| Output Low to High Logic State | tPLHC2X | _ | _ | 65 | ns |
| Output High to Low Logic State | tPHLC2X | | | 85 | ns |
| Transition Times (Figure 4) | | | | 05 | |
| Output Low to High State | tTLHC | _ | _ | 25 25 | l ns |
| Output High to Low State | tTHLC | | | 25 | 113 |
| 2 x fo CHARACTERISTICS | | | | | |
| Delay Times (Referenced to 4 x fo) (Figure 4) | | | | | |
| Output Low to High Logic State | tPLH2X | - | _ | 50 | ns |
| Output High to Low Logic State | tPHL2X | | _ | 65 | ns |
| Delay Time (Referenced to MPU ϕ 1) (Figure 4) | | | | | |
| Output High to Low Logic State | tPHL2XM1 | | | İ | ns |
| (fo = 1.0 MHz) | | 365 | - | - | 1 |
| (fo = 1.5 MHz) | | 220 | | | |
| Transition Times (Figure 4) | | | ľ | 25 | |
| Output Low to High Logic State | tTLH2X | _ | _ | 25 25 | ns |
| Output High to Low Logic State | tTHL2X | | | 25 | ns |
| 4 x fo CHARACTERISTICS | | | | | |
| Delay Times (Referenced to Ext. In) (Figure 4) | | | | |] |
| Output Low to High Logic State | tPLH4X | - ' | _ | 50 | ns |
| Output High to Low Logic State | tPHL4X | | | 30 | ns |
| Transition Time (Figure 4) | | | 1 | | |
| Output Low to High Logic State | tTLH4X | _ | _ | 25 | ns |
| Output High to Low Logic State | tTHL4X | | | 25 | ns |
| MEMORY READY CHARACTERISTICS | | | • | | |
| Set-Up Times (Figure 5) | | | 1 | | Ì |
| Low Input Logic State | tSMRL | 55 | - | _ | ns |
| High Input Logic State | [†] SMRH | 75 | ļ | | ns |
| Hold Time (Figure 5) | | 4.0 | | | |
| Low Input Logic State | tHMRL | 10 | | | ns |
| DMA/REFRESH REQUEST CHARACTERISTICS | | | | | |
| Set-Up Times (Figure 6) | | 0.5 | 1 | 1 | |
| Low Input Logic State | tSDRL | 65 75 | _ | _ | ns |
| High Input Logic State | tsdrh | 75 | <u> </u> | | ns |
| Hold Time (Figure 6) | | 10 | | _ | |
| Low Input Logic State | tHDRL | 10 | | <u> </u> | ns |
| DMA/REFRESH GRANT CHARACTERISTICS | | | | · | |
| Delay Time Referenced to Memory Clock (Figure 6) | | | | | |
| Output Low to High Logic State | ^t PLHG | -15 | _ | +25 | ns |
| Output High to Low Logic State | [†] PHLG | -25 | | +15 | ns |
| Transition Times (Figure 6) | | | } | | |
| Output Low to High Logic State | ^t TLHG | - | _ | 25 | ns |
| Output High to Low Logic State | tTHLG | | | 25 | ns |
| RESET CHARACTERISTICS | | | | т | |
| Delay Time Referenced to Power-On Reset (Figure 7) | | | | İ | |
| Output Low to High Logic State | †PLHR | | - | 1000 | ns |
| Output High to Low Logic State | tPHLR | | | 250 | ns |
| Transition Times (Figure 7) | | | | 400 | |
| Output Low to High Logic State | ^t TLHR | | _ | 100 | ns |
| Output High to Low Logic State | t THLR | _ | | 50 | ns |

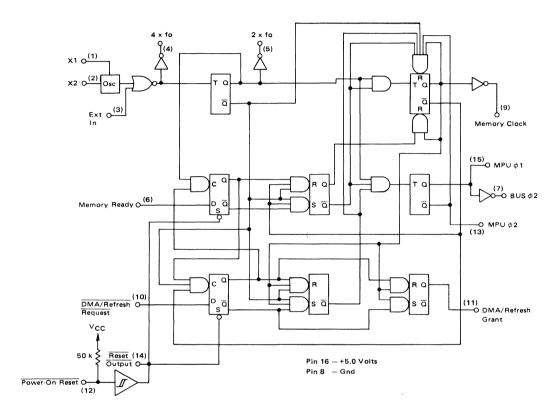
DESCRIPTION OF PIN FUNCTIONS

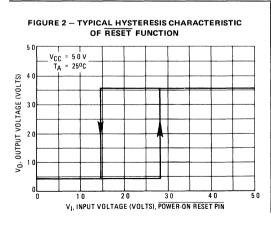
- MPU φ1
 MPU φ2 - Capable of driving the $\phi1$ and $\phi2$ inputs on two MC6800s

- A x for unning oscillator at four times the MPU clock rate useful for a system sync signal
 A free running oscillator at two times the MPU clock rate
 A free running oscillator at two times the MPU clock rate
 A free running oscillator at two times the MPU clock rate
 An asynchronous input used to freeze the MPU clocks in the \$0 \text{ high system sync signal}
 A free running oscillator at two times the MPU clock rate
 An asynchronous input used to freeze the MPU clock rate
 A synchronous input used to synchronize the refresh or DMA operation to the MPU
 MEMORY READY
 An asynchronous input used to freeze the MPU clocks in the \$0 \text{ low, \$0 \text{ high state for slow}}
 MEMORY READY
 An asynchronous opput used to freeze the MPU clocks in the \$0 \text{ low, \$0 \text

 - X1, X2EXT IN
 - Provision to attach a series resonant crystal or RC network
 Allows driving by an external TTL signal to synchronize the MPU to an external system

FIGURE 1 - BLOCK DIAGRAM





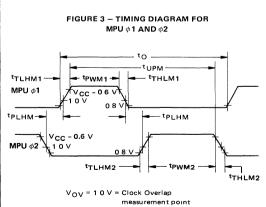


FIGURE 4 — TIMING DIAGRAM FOR NON-STRETCHED OPERATION (Memory Ready and $\overline{DMA/Refresh}$ Request held high continuously) Ext. In Input Voltage: 0 V to 3.0 V, f = 8.0 MHz, Duty Cycle = 50%, tTLHEX = tTHLEX = 5.0 ns

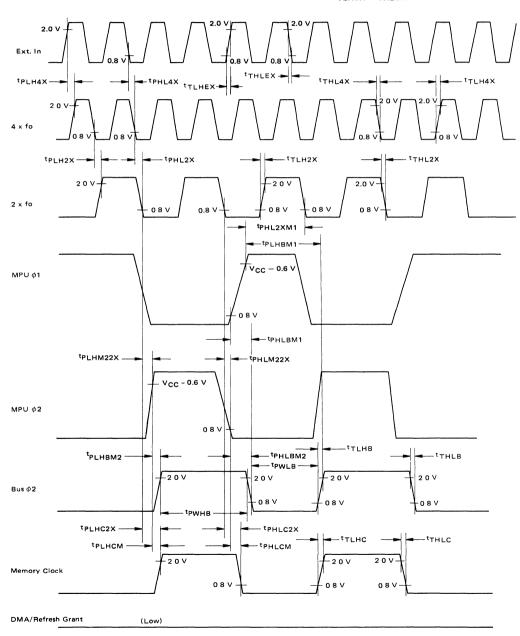


FIGURE 5 – TIMING DIAGRAM FOR MEMORY READY STRETCH OPERATION (Minimum Stretch Shown)

Input Voltage: 3.0 to 0 V, tTHLMR = tTLHMR = 5.0 ns

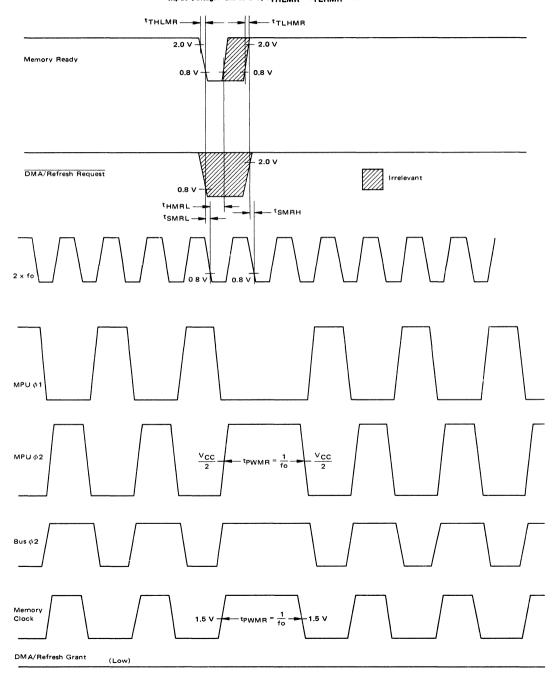


FIGURE 6 — TIMING DIAGRAM FOR DMA/REFRESH REQUEST STRETCH OPERATION (Minimum Stretch Shown)

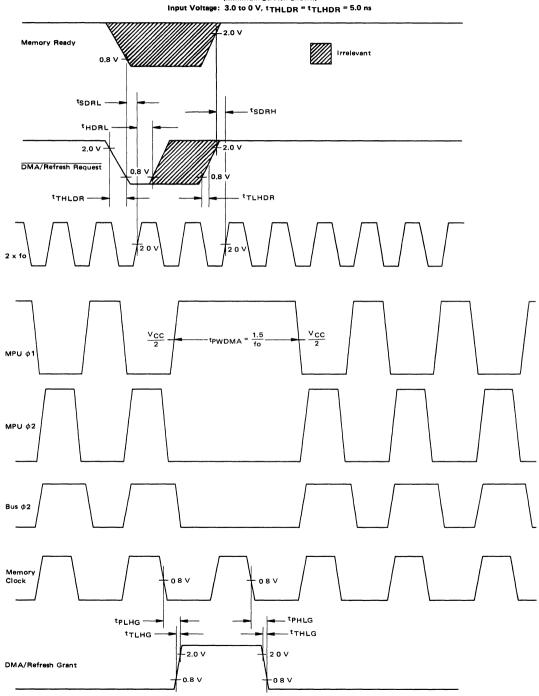


FIGURE 7 - POWER ON RESET Input Voltage: 0 to 5.0 V, f = 100 kHz - Pulse Width = 1.0 μ s, t_{TLH} = t_{THL} = 25 ns

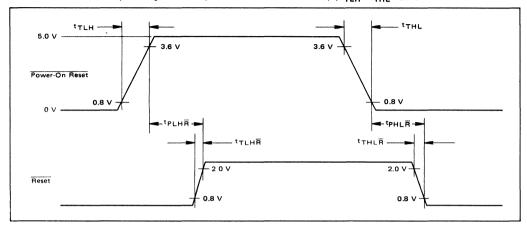
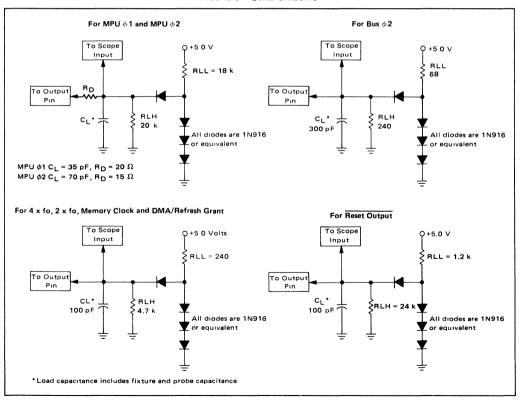


FIGURE 8 - LOAD CIRCUITS



APPLICATIONS INFORMATION

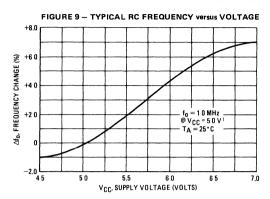


FIGURE 10 – TYPICAL RC FREQUENCY versus TEMPERATURE

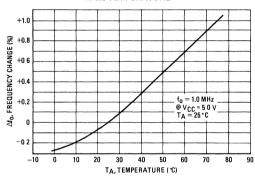
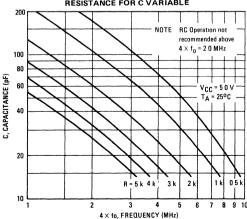


FIGURE 11 – TYPICAL FREQUENCY versus RESISTANCE FOR C VARIABLE



GENERAL

The MC6875 Clock Generator/Driver should be located on the same board and within two inches of the MC6800 MPU. Series damping resistors of 10-30 ohms may be utilized between the MC6875 and the MC6800 on the $\phi1$ and $\phi2$ clocks to suppress overshoot and reflections.

The VCC pin (pin 16) of the MC6875 should be bypassed to the ground pin (pin 8) at the package with a 0.1 µF capacitor. Because of the high peak currents associated with driving highly capacitive loads, an adequately large ground strip to pin 8 should be used on the MC6875. Grounds should be carefully routed to minimize coupling of noise to the sensitive oscillator inputs. Unnecessary grounds or ground planes should be avoided near pin 2 or the frequency determining components. These components should be located as near as possible to the respective pins of the MC6875. Stray capacitance near pin 2 or the crystal, can affect the frequency. The can of the crystal or the C of the R-C oscillator should be connected as directly as possible to pin 8.

Unused inputs should be connected to VCC or ground.

Memory Ready, DMA/Refresh Request and Power-On Reset should be connected to VCC when not used.

The External Input should be connected to ground when not used.

OSCILLATOR

A tank circuit tuned to the desired crystal frequency connected between terminals X_1 and X_2 as shown in Figure 12, is recommended to prevent the oscillator from starting at other than the desired frequency. The $1k\Omega$ resistor reduces the Q sufficiently to maintain stable crystal control. Crystal manufacturers may recommend a capacitance (CL) to be used in series with the crystal for optimum performance at series resonance.

See Figures 9 and 10 for typical oscillator temperature and VCC supply dependence for R-C operation.

FIGURE 12 - OSCILLATOR-CRYSTAL OPERATION

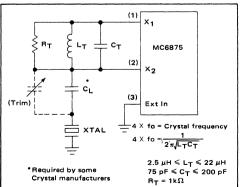
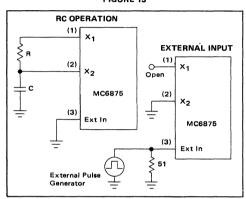


TABLE 1 - OSCILLATOR COMPONENTS

| | CIRCUIT METERS | APPROXIMATE CRYSTAL PARAMETERS | | | | CTS KNIGHTS 400 REIMANN AVE. SANDWICH, IL 60548 | McCOY ELECT. CO. WATTS & CHESTNUTS STS. MT. HOLLY SPRING, PA 17065 | TYCO CRYSTAL PRODUCTS 3940 W. MONTECITO PHOENIX, AZ 85019 |
|----------------------|-------------------|-----------------------------------|----------|-----------------------|-----------|---|--|--|
| L _T μH | C _T | R _S Ohms | Co pF | C ₁ mpF | fo MHz | (815) 786-8411 | (717) 486-3411 | (602) 272-7945 |
| 10 | 150 | 15-75 | 3-6 | 12 | 4.0 | MP-04A * 390 pF | 113-31 | 150-3260 |
| 4.7 | 82 | 8-45 | 4-7 | 23 | 8.0 | MP-080 * 47 pF | 113-32 | 150-3270 |

FIGURE 13

Inductors may be obtained from Coilcraft, Cary, IL 60013 (312) 639-2361



To precisely time a crystal to desired frequency, a variable trimmer capacitor in the range of 7 to 40 pF would typically be used. Note it is not a recommended practice to tune the crystal with a parallel load capacitance.

The table above shows typical values for C_T and L_T , typical crystal characteristics, and manufacturers' part numbers for 4.0 and 8.0 megahertz operation.

The MC6875 will function as an R-C oscillator when connected as shown in Figure 13. The desired output frequency (M ϕ 1) is approximately:

Formula 320 C in picofarads
$$4 \times \text{fo} \approx \frac{320}{\text{C (R+ .27)} + 23}$$
 R in K ohms (See Figure 11) $4 \times \text{fo in Megahertz}$

It would be desirable to select a capacitor greater than 15 pF to minimize the effects of stray capacitance. It is also desirable to keep the resistor in the 1 to 5 k Ω range. There is a nominal 270 Ω resistor internally at X1 which is in series with the external R. By keeping the external R as large as possible, the effects due to process variations of the internal resistor on the frequency will be reduced. There will, however, still be some variation in frequency in a production lot both from the resistance variations, external and internal, and process variations of the input switching thresholds. Therefore, in a production system, it is recommended a potentiometer be placed in series with a fixed R between X1 and X2.

POWER-ON RESET

As the power to the MC6875 comes up, the Reset Output will be in a high impedance state and will not give

a solid VOL output level until VCC has reached 3.5 to 4.0 V. During this time transients may appear on the clock outputs as the oscillator begins to start. This happens at approximately VCC = 3 V. At some VCC level above that, where Reset Output goes low, all the clock outputs will begin functioning normally. This phenomenon of the start-up sequence should not cause any problems except possibly in systems with battery back-up memory. The transients on the clock lines during the time the Reset Output is high impedance could initiate the system in some unknown mode and possibly write into the backup memory system. Therefore in battery backup systems, more elaborate reset circuitry will be required.

Please note that the Power-On Reset input pin of the MC6875 is not suitable for use with a manual MPU reset switch if the DMA/Ref Req or Memory Ready inputs are going to be used. The power on reset circuitry is used to initialize the internal control logic and whenever the input is switched low, the MC6875 is irresponsive to the DMA/Ref Req or Memory Ready inputs. This may result in the loss of dynamic memory and/or possibly a byte of slow static memory. The circuit of Figure 14 is recommended for applications which do not utilize the DMA/Ref Req or Memory Ready inputs. The circuit of Figure 15 is recommended for those applications that do.

FIGURE 14 – MANUAL RESET FOR APPLICATIONS NOT USING DMA/REFRESH REQUEST OR MEMORY READY INPUTS

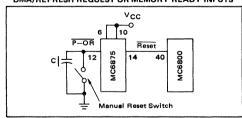
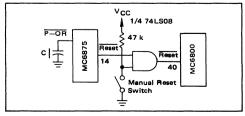


FIGURE 15 — MANUAL RESET FOR SYSTEMS USING DYNAMIC RAM OR SLOW STATIC RAM IN CONJUNCTION WITH MEMORY READY OR DMA/REFRESH REQUEST INPUTS



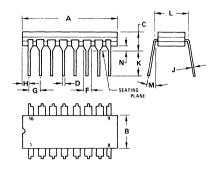
NOTE:

Operation of the MC6875AL over the full military temperature range (to maximum T_A) will result in excessive operating junction temperature.

The use of a clip on 16 pin heat sink similar to AAVID Engineering, Inc., Model 5007 (R $_{\theta}$ CA = 18°C/W) is recommended above TA \approx 95°C.

Contact AAVID Engineering, Inc. 30 Cook Court Laconia, New Hampshire 03246 Tel. (603) 524-4443

OUTLINE DIMENSIONS



| | MILLIN | METERS | INCHES | |
|-----|--------|-----------------|-----------|-----------------|
| DIM | MIN | MAX | MIN | MAX |
| Α | 19 05 | 19.81 | 0.750 | 0 780 |
| В | 6.22 | 6 98 | 0.245 | 0 275 |
| C | 4 06 | 5.08 | 0 160 | 0.200 |
| D | 0.38 | 0.51 | 0.015 | 0.020 |
| F | 1.40 | 1 65 | 0.055 | 0 065 |
| G | 2.54 | BSC | 0.100 BSC | |
| Н | 0.51 | 1 14 | 0.020 | 0.045 |
| J | 0.20 | 0 30 | 0.008 | 0.012 |
| K | 3.18 | 4.06 | 0 125 | 0.160 |
| L | 7 37 | 7 87 | 0 290 | 0 310 |
| M | - | 15 ⁰ | _ | 15 ⁰ |
| N | 0.51 | 1.02 | 0.020 | 0.040 |

NOTES

- 1 LEADS WITHIN 0.13 mm (0 005) RADIUS OF TRUE POSITION AT SEATING PLANE AT MAXIMUM MATERIAL CONDITION
- 2 PKG INDEX NOTCH IN LEAD
- NOTCH IN CERAMIC OR INK DOT 3 DIM "L" TO CENTER OF LEADS WHEN FORMED PARALLEL

CASE 620-02

 $R_{\theta JA} = 100^{\circ} C/W (Typ)$

 $R_{\theta JC(peak)} = 15^{\circ}C/W$

THERMAL INFORMATION

The maximum power consumption an integrated circuit can tolerate at a given operating ambient temperature, can be found from the equation

$$P_{D(T_A)} = \frac{T_{J(max)} - T_A}{R_{\theta JA}}$$

Where $P_{D(T_A)}$ = Power Dissipation allowable at a given operating ambient temperature. This must be greater than

the sum of the products of the supply voltages and supply currents at the worst case operating condition

T_{J(max)} = Maximum Operating Junction Temperature as listed in the Maximum Ratings Section

TA = Maximum Desired Operating Ambient

Temperature

 $R_{\theta JA}$ = Thermal Resistance Junction to Ambient

 $R\theta JC$ = Thermal Resistance Junction to Case



QUAD THREE-STATE BUS TRANSCEIVER

This quad three-state bus transceiver features both excellent MOS or MPU compatibility, due to its high impedance PNP transistor input, and high-speed operation made possible by the use of Schottky diode clamping. Both the —48 mA driver and —20 mA receiver outputs are short-circuit protected and employ three-state enabling inputs.

The device is useful as a bus extender in systems employing the M6800 family or other comparable MPU devices. The maximum input current of 200 μA at any of the device input pins assures proper operation despite the limited drive capability of the MPU chip. The inputs are also protected with Schottky-barrier diode clamps to suppress excessive undershoot voltages.

The MC8T26A is identical to the NE8T26A and it operates from a single +5 V supply.

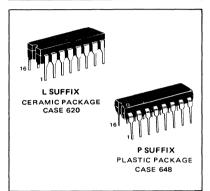
- High Impedance Inputs
- Single Power Supply
- High Speed Schottky Technology
- Three-State Drivers and Receivers
- Compatible with M6800 Family Microprocessor

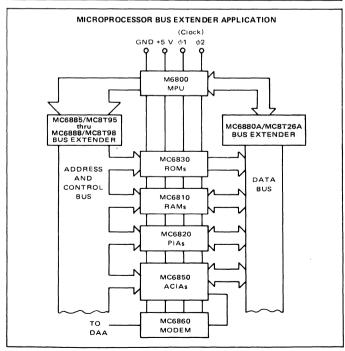
MC6880A MC8T26A

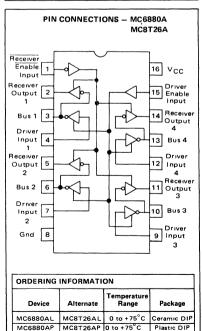
This device may be ordered under either of the above type numbers.

QUAD THREE-STATE BUS TRANSCEIVER

MONOLITHIC SCHOTTKY INTEGRATED CIRCUITS







MAXIMUM RATINGS (TA = 25°C unless otherwise noted.)

| Rating | Symbol | Value | Unit |
|-------------------------------------|------------------|------------|------|
| Power Supply Voltage | Vcc | 8.0 | Vdc |
| Input Voltage | V _I | 5.5 | Vdc |
| Junction Temperature | Tj | | °C |
| Ceramic Package | | 175 | |
| Plastic Package | Į. | 150 | |
| Operating Ambient Temperature Range | TA | 0 to +75 | °С |
| Storage Temperature Range | T _{stg} | -65 to+150 | °С |

ELECTRICAL CHARACTERISTICS (4.75 V < V_{CC} < 5.25 V and 0^{o} C < T_A < 75^{o} C unless otherwise noted.)

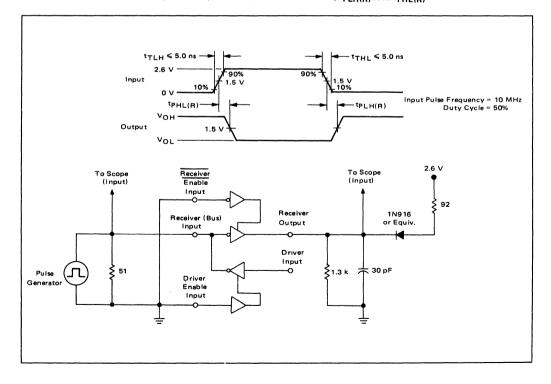
| Characteristic | Symbol | Min | Тур | Max | Unit |
|---|--------------------|-----|-----|------|------|
| Input Current - Low Logic State | | | | | |
| (Receiver Enable Input, VIL(RE) = 0 4 V) | IL(RE) | - | _ | -200 | μА |
| (Driver Enable Input, VIL(DE) = 0 4 V) | IL(DE) | | - | -200 | |
| (Driver Input, VIL(D) = 0 4 V) | IL(D) | - | - | -200 | |
| (Bus (Receiver) Input, V _{IL(B)} = 0 4 V) | lIL(B) | _ | _ | -200 | |
| Input Disabled Current — Low Logic State | IL(D) DIS | | | | |
| (Driver Input, V _{IL(D)} = 0.4 V) | 12(8) 810 | - | - | - 25 | μΑ |
| Input Current-High Logic State | | | | | |
| (Receiver Enable Input, VIH(RE) = 5 25 V) | IH(RE) | _ | - | 25 | μΑ |
| (Driver Enable Input, VIH(DE) = 5 25 V) | IH(DE) | _ | _ | 25 | |
| (Driver Input, VIH(D) = 5 25 V) | IH(D) | _ | - | 25 | |
| (Receiver Input, V _{IH(B)} = 5.25 V) | ЧН(В) | _ | | 100 | |
| Input Voltage - Low Logic State | | | | | |
| (Receiver Enable Input) | VIL(RE) | - | _ | 0 85 | V |
| (Driver Enable Input | VIL(DE) | - | _ | 0.85 | |
| (Driver Input) | VIL(D) | - | _ | 0 85 | |
| (Receiver Input) | VIL(B) | | - | 0 85 | |
| Input Voltage — High Logic State | | | | | |
| (Receiver Enable Input) | VIH(RE) | 20 | _ | | V |
| (Driver Enable Input) | VIH(DE) | 20 | _ | _ | |
| (Driver Input) | V _{IH(D)} | 20 | _ | l – | |
| (Receiver Input) | V _{IH(B)} | 2.0 | _ | - | |
| Output Voltage — Low Logic State | | | | | |
| (Bus Driver) Output, I _{OL} (B) = 48 mA) | V _{OL(B)} | _ | _ | 0.5 | \ |
| (Receiver Output, IOL(R) = 20 mA) | VOL(R) | _ | | 0.5 | - |
| Output Voltage - High Logic State | - OLIN | | | | |
| (Bus (Driver) Output, I _{OH(B)} = -10 mA) | V _{OH(B)} | 2.4 | 3 1 | _ | l v |
| (Receiver Output, I _{OH(R)} = -2.0 mA) | VOH(R) | 2.4 | 3 1 | _ | |
| (Receiver Output, $I_{OH(R)} = -100/\mu A$, $V_{CC} = 5.0 \text{ V}$) | 100(0) | 3.5 | _ | _ | |
| | | 0.0 | | | |
| Output Disabled Leakage Current — High Logic State | | | | 100 | ١ . |
| (Bus Driver) Output, V _{OH(B)} = 2.4 V) | OHL(B) | _ | _ | 100 | μΑ |
| (Receiver Output, V _{OH(R)} = 2.4 V) | OHL(R) | | | 100 | |
| Output Disabled Leakage Current — Low Logic State | | | | | |
| (Bus Output, V _{OL(B)} = 0.5 V) | OLL(B) | _ | - | -100 | μΑ |
| (Receiver Output, VOL(R) = 0.5 V) | IOLL(R) | | | -100 | |
| Input Clamp Voltage | 1 1 | | | | |
| (Driver Enable Input $I_{ID(DE)} = -12 \text{ mA}$) | VIC(DE) | _ | _ | -10 | \ |
| (Receiver Enable Input I _{IC(RE)} = +12 mA) | VIC(RE) | - | - | -10 | 1 |
| (Driver Input I _{IC(D)} = -12 mA) | VIC(D) | _ | | -10 | |
| Output Short-Circuit Current, V _{CC} = 5 25 V (1) | | | | | |
| (Bus (Driver) Output) | IOS(B) | -50 | _ | -150 | mA |
| (Receiver Output) | los(R) | -30 | | -75 | |
| Power Supply Current | ¹cc | - | _ | 87 | mA |
| $(V_{CC} = 5.25 V)$ | | | 1 | Ī | 1 |

⁽¹⁾ Only one output may be short-circuited at a time.

SWITCHING CHARACTERISTICS (Unless otherwise noted, specifications apply at T_A = 25°C and V_{CC} = 5.0 V)

| Characteristic | Symbol | Figure | Min | Max | Unit |
|---|----------------------|--------|-----|-----|------|
| Propagation Delay Time from Receiver (Bus) Input to High Logic State Receiver Output | tPLH(R) | 1 | - | 14 | ns |
| Propagation Delay Time from Receiver (Bus) Input to Low Logic State Receiver Output | tPHL(R) | 1 | - | 14 | ns |
| Propagation Delay Time from Driver Input to High Logic State Driver (Bus) Output | tPLH(D) | 2 | - | 14 | ns |
| Propagation Delay Time from Driver I nput to Low Logic State Driver (Bus) Output | tPHL(D) | 2 | - | 14 | ns |
| Propagation Delay Time from Receiver Enable Input to High Impedance (Open) Logic State Receiver Output | ^t PLZ(RE) | 3 | _ | 15 | ns |
| Propagation Delay Time from Receiver Enable Input to Low Logic Level Receiver Output | tPZL(RE) | 3 | - | 20 | ns |
| Propagation Delay Time from Driver Enable Input to High Impedance Logic State Driver (Bus) Output | tPLZ(DE) | 4 | _ | 20 | ns |
| Propagation Delay Time from Driver Enable Input to Low Logic State Driver (Bus) Output | tPZL(DE) | 4 | _ | 25 | ns |

FIGURE 1 – TEST CIRCUIT AND WAVEFORMS FOR PROPAGATION DELAY FROM BUS (RECEIVER) INPUT TO RECEIVER OUTPUT, $t_{PLH(R)}$ AND $t_{PHL(R)}$



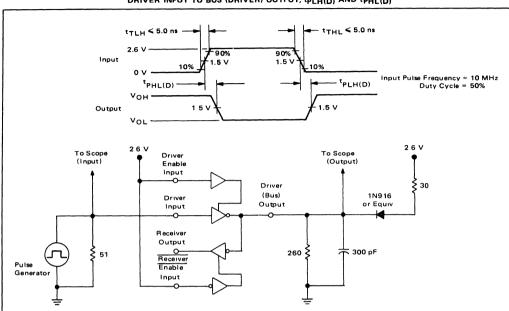


FIGURE 2 — TEST CIRCUIT AND WAVEFORMS FOR PROPAGATION DELAY TIME FROM DRIVER INPUT TO BUS (DRIVER) OUTPUT, tpLH(D) AND tpHL(D)

FIGURE 3 – TEST CIRCUIT AND WAVEFORMS FOR PROPAGATION DELAY TIME FROM RECEIVER ENABLE INPUT TO RECEIVER OUTPUT, $t_{PLZ(RE)}$ AND $t_{PZL(RE)}$

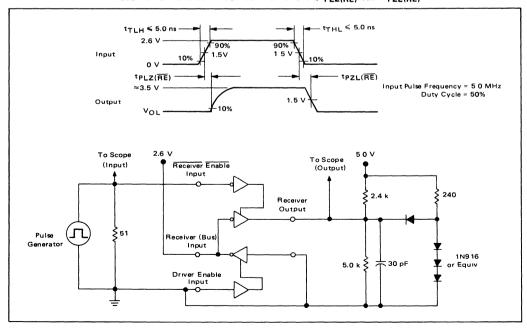


FIGURE 4 - TEST CIRCUIT AND WAVEFORMS FOR PROPAGATION DELAY TIMES FROM DRIVER ENABLE INPUT TO DRIVER (BUS) OUTPUT, $t_{PLZ(DE)}$ AND $t_{PZL(DE)}$

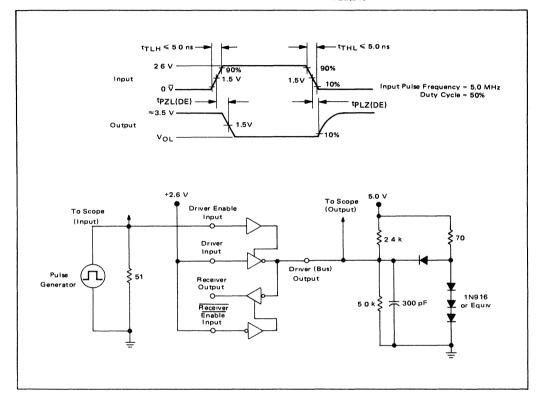
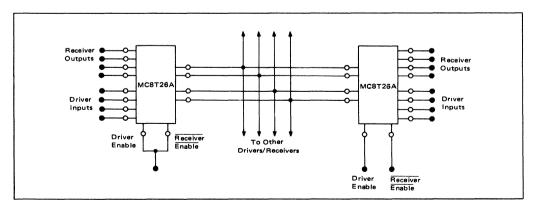
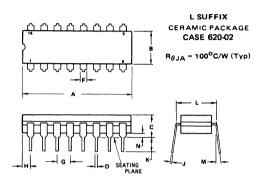


FIGURE 5 - BIDIRECTIONAL BUS APPLICATIONS

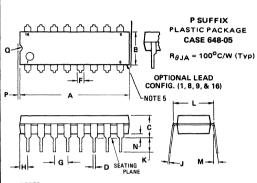




NOTES:

- LEADS WITHIN 0.13 mm (0.005) RADIUS
 OF TRUE POSITION AT SEATING PLANE
 AT MAXIMUM MATERIAL CONDITION
 PKG. INDEX. NOTCH IN LEAD
- NOTCH IN CERAMIC OR INK DOT
- DIM "L" TO CENTER OF LEADS WHEN FORMED PARALLEL

| | MILLIN | METERS | INC | HES |
|-----|--------|--------|-----------|-------|
| DIM | MIN | MAX | MIN | MAX |
| A | 19.05 | 19.81 | 0.750 | 0.780 |
| В | 6.22 | 6.98 | 0.245 | 0.275 |
| C | 4.06 | 5.08 | 0.160 | 0.200 |
| D | 0.38 | 0.51 | 0.015 | 0.020 |
| F | 1.40 | 1.65 | 0.055 | 0.065 |
| G | 2.54 | BSC | 0.100 BSC | |
| H | 0.51 | 1.14 | 0.020 | 0.045 |
| J | 0.20 | 0.30 | 0.008 | 0.012 |
| K | 3.18 | 4.06 | 0.125 | 0.160 |
| L | 7 37 | 7.87 | 0.290 | 0.310 |
| M | - | 150 | | 150 |
| N | 0.51 | 1.02 | 0.020 | 0.040 |



NOTES.

- 1. LEADS WITHIN 0.13 mm (0.005) RADIUS OF TRUE POSITION AT SEATING PLANE AT MAXIMUM MATERIAL CONDITION.
- 2. DIMENSION "L" TO CENTER OF LEADS WHEN FORMED PARALLEL.
- 3. DIMENSION "B" DOES NOT INCLUDE MOLD FLASH.
- 4. "F" DIMENSION IS FOR FULL LEADS. "HALF" LEADS ARE OPTIONAL AT LEAD POSITIONS 1 8 9 and 16)
- 5. ROUNDED CORNERS OPTIONAL.

| | MILLIM | ETERS | ERS INCHES | | |
|-----|----------|-------|------------|-------|--|
| DIM | MIN | MAX | MIN | MAX | |
| A | 18.80 | 21.34 | 0.740 | 0.840 | |
| В | 6.10 | 6.60 | 0.240 | 0.260 | |
| C | 4.06 | 5.08 | 0.160 | 0.200 | |
| D | 0.38 | 0.53 | 0.015 | 0.021 | |
| F | 1.02 | 1.78 | 0.040 | 0.070 | |
| G | 2 54 | BSC | 0.100 | BSC | |
| H | 0.38 | 2.41 | 0.015 | 0.095 | |
| J | 0.20 | 0.38 | 0.008 | 0.015 | |
| K | 2.92 | 3.43 | 0.115 | 0.135 | |
| L | 7.62 BSC | | 0.300 BSC | | |
| M | 00 | 100 | 00 | 100 | |
| N | 0.51 | 1.02 | 0.020 | 0.040 | |

THERMAL INFORMATION

The maximum power consumption an integrated circuit can tolerate at a given operating ambient temperature, can be found from the equation

$$P_{D(T_A)} = \frac{T_{J(max)} - T_A}{R_{\theta JA}(Typ)}$$

Where. $P_{D(T_A)}$ = Power Dissipation allowable at a given operating ambient temperature. This must be greater than

the sum of the products of the supply voltages and supply currents at the worst case operating condition.

T_{J(max)} = Maximum Operating Junction Temperature as listed in the Maximum Ratings Section

TA = Maximum Desired Operating Ambient Temperature

 $R_{\theta}JA(Typ)$ = Typical Thermal Resistance Junction to Ambient



SN74LS783 MC6883

Advance Information

SYNCHRONOUS ADDRESS MULTIPLEXER

The SN74LS783/MC6883 brings together the MC6809E (MPU), the MC6847 (Color Video Display Generator) and dynamic RAM to form a highly effective, compact and cost effective computer and display system.

- MC6809E, MC6800, MC6801E, MC68000 and MC6847 (VDG) Compatible
- Transparent MPU/VDG/Refresh
- RAM size 4K, 8K, 16K, 32K or 64K Bytes (Dynamic or Static)
- Addressing Range 96K Bytes
- Single Crystal Provides All Timing
- Register Programmable:

VDG Addressing Modes VDG Offset (0 to 64K)

RAM Size

Page Switch

MPU Rate (Crystal ÷ 16 or ÷ 8)

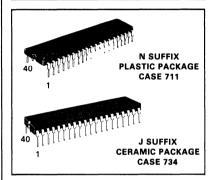
MPU Rate (Address Dependent or Independent)

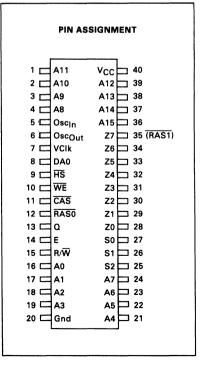
- System "Device Selects" Decoded 'On Chip'
- Timing is Optimized for Standard Dynamic RAMs
- +5.0 V Only Operation
- Easy Synchronization of Multiple SAM Systems
- DMA Mode

SYSTEM BLOCK DIAGRAM Device Selects 8 [TV Display Section SN74LS138 is Optional S0-S2 CIL DA0 SN74LS783/ VDG Address Δ0-Δ15 MC6883 MC6847 uc SAM R/W 14 MHz Data DD0-DD7 То CAS 70-77 ROMs MC6809E 1/0 MPU SN74LS273 MC1372 RAS WF or RGB Ckt DYNAMIC D0-D7 RAM Data Data 4K, 8K, 16K 0 32K or 64K COLOR BYTES (OR B/W) SN74LS244 0 TV

SYNCHRONOUS ADDRESS MULTIPLEXER

LOW POWER SCHOTTKY





MAXIMUM RATINGS ($T_A = 25^{\circ}C$ unless otherwise noted.)

| Rating | Symbol | Value | Unit |
|-------------------------------------|------------------|-------------------------|------|
| Power Supply Voltage | Vcc | -0.5 to +7.0 | Vdc |
| Input Voltage (Except Oscin) | V _I | -0.5 to 10 | Vdc |
| Input Current (Except Oscin) | l _l | -30 to +5.0 | mA |
| Output Voltage | ٧o | -0.5 to +7.0 | Vdc |
| Operating Ambient Temperature Range | TA | 0 to +70 | °C |
| Storage Temperature Range | T _{stg} | -65 to +150 | °C |
| Input Voltage Oscin | ViOscin | -0.5 to V _{CC} | Vdc |
| Input Current Oscin | loscin | -0.5 to +5.0 | mA |

RECOMMENDED OPERATING CONDITIONS

| Rating | Symbol | Value | Unit |
|-------------------------------------|--------|--------------|------|
| Power Supply Voltage | Vcc | 4.75 to 5.25 | Vdc |
| Operating Ambient Temperature Range | TA | 0 to +70 | °C |

DC CHARACTERISTICS (Unless otherwise noted specifications apply over recommended power supply and temperature ranges.)

| Characteristic | Symbol | Min | Тур | Max | Units |
|---|-----------------------------------|--------------------------------------|---------------|---------------------------|-------|
| Input Voltage — High Logic State | ViH | 2.0 | _ | _ | ٧ |
| Input Voltage — Low Logic State | VIL | _ | _ | 0.8 | ٧ |
| Input Clamp Voltage (V _{CC} = Min, I _{in} = -18 mA) All Inputs Except Osc _{In} | ViK | _ | _ | - 1.5 | V |
| Input Current — High Logic State at Max Input Voltage (VCC = Max, Vin = 5.25 V) VCIk Input (VCC = Max, Vin = 5.25 V) DA0 Input (VCC = Max, Vin = 5.25 V) Osc _{Out} Input (VCC = Max, Vin = 7.0 V) All Other Inputs Except Osc _{In} | lı | 1111 | - - | 200 100 250 100 | μА |
| Input Current High Logic State (VCC = Max, Vin = 2.7 V) All Inputs Except VClk, Oscin* | IIH | _ | _ | 20 | μΑ |
| Input Current — Low Logic State (VCC = Max, Vin = 0.4 V) DA0 Input (VCC = Max, Vin = 0.4 V) VCIk Input (VCC = Max, Vin = 0.4 V, Oscin = Gnd) Osc _{Out} Input (VCC = Max, Vin = 0.4 V) All Other Inputs Except Oscin | Iμ | - | -30 | - 1.2 - 60 - 8 4 | mA |
| Output Voltage — High Logic State (V _{CC} = Min, I _{OH} = -1.0 mA) RASO, RAS1, CAS, WE (V _{CC} = Min, I _{OH} = -0.2 mA) E, Q (V _{CC} = Min, I _{OH} = -0.2 mA) All Other Outputs | VOH(C) VOH(E) VOH | 3.0 V _{CC} - 0.75 2.7 | = | _ | ٧ |
| Output Voltage — Low Logic State (VCC = Min, I _{OL} = 8.0 mA) RAS0, RAS1, CAS, WE (VCC = Min, I _{OL} = 4.0 mA) E, Q Outputs (VCC = Min, I _{OL} = 0.8 mA) VCIk Output (VCC = Min, I _{OL} = 4.0 mA) All Other Outputs | VOL(C) VOL(E) VOL(V) VOL | - - - - | <u>-</u> - | 0.5 0.5 0.6 0.5 | V |
| Power Supply Current | Icc | _ | 180 | 230 | mA |
| Output Short-Circuit Current | los | 30 | | 225 | mA |

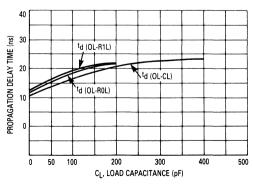
^{*}Including Oscout (when Oscin is grounded).

AC CHARACTERISTICS (4.75 V≤V_{CC}≤5.25 V and 0≤T_A≤70°C, unless otherwise noted).

| Characteristic | Symbol | Min | Тур | Max | Units |
|---|--|----------|--------------|-----|-------|
| Propagation Delay Times (See Circuit in Figure 9) Oscillator-In 🔍 to Oscillator-Out Oscillator-In 🚅 to Oscillator-Out | | _ | 3.0 20 | _ | ns |
| $(C_L = 195 \text{ pF}) \text{ A0 thru A15 to Z0, Z1, Z2 thru Z7}$ $(C_L = 30 \text{ pF}) \text{ A0 thru A15, R/W to S0, S1, S3}$ | ^t d(A-Z) ^t d(A-S) | _ | 28 18 | _ | |
| (C _L = 95 pF) Oscillator-Out ₹Lto RASO → (C _L = 95 pF) Oscillator-Out ₹Lto RASO ₹L | td(OL-R0H) td(OL-R0L) | _ | 20 18 | | |
| (C _L = 95 pF) Oscillator-Out ₹Lto RAS1(C _L = 95 pF) Oscillator-Out ₹Lto RAS1 ₹L | ^t d(OL-R1H) ^t d(OL-R1L) | | 22 20 | _ | |
| (C _L = 195 pF) Oscillator-Out ₹ to CAS ✔ (C _L = 195 pF) Oscillator-Out ₹ to CAS ₹ | td (OL-CH) td(OL-CL) | _ | 20 20 | 1 1 | |
| (C _L = 195 pF) Oscillator-Out $^{\sim}$ to $\overline{\text{WE}}$ $^{\sim}$ (C _L = 195 pF) Oscillator-Out $^{\sim}$ to $\overline{\text{WE}}$ | td(OL-WH) td(OL-WL) | <u>-</u> | 22 40 | _ | |
| (C _L = 100 pF) Oscillator-Out | td(OL-EH) td(OL-EL) | | 55 25 | | |
| (C _L = 100 pF) Oscillator-Out | td(OL-QH) | _ | 55 25 | _ | |
| (C _L = 30 pF) Oscillator-Out of to VClk of (C _L = 30 pF) Oscillator-Out of to VClk of to VClk of the vertical of the vertic | td(OH-VH) | _ | 50 65 | _ | |
| (C _L = 195 pF) Oscillator-Out → to Row Address (C _L = 195 pF) Oscillator-Out → to Column Address | td(OL-AR) td(OL-AC) | _ | 36 33 | _ | |
| (C _L = 15 pF) Oscillator-Out to DAO | td(OL-DH) | _ | - 15 + 15 | | |
| $(C_L = 95 \text{ pF on } \overline{RAS}, C_L = 195 \text{ pFon } \overline{CAS}) \overline{CAS} $ to \overline{RAS} | td(CL-RH) | _ | 208 | _ | |
| Setup Time for A0 thru A15, R/\overline{W} Rate = -16 Rate = -8 | t _{su} (A) | _ | 28 28 | _ | ns |
| Hold Time for A0 thru A15, R/\overline{W} Rate = -16 Rate = -8 | ^t h(A) | = | 30 30 | _ | ns |
| Width of HS Low ² | twL(HS) | 2.0 | 5.0 | 6.0 | μs |

Notes: 1 When using the SAM with an MC6847, the rising edge of DA0 is confined within the range shown in the timing diagrams (unless the synchronizing process is incomplete). The synchronization process requires a maximum of 32 cycles of Oscout for completion.

FIGURE 1 — PROPAGATION DELAY TIMES VERSUS LOAD CAPACITANCE



^{2.} tWL(HS) wider than 6 0 μs may yield more than 8 sequential refresh addresses

PIN DESCRIPTION TABLE

| | | Name | No. | Function |
|-------------|-------------------------|--|--|--|
| | Power | V _{CC} Gnd | 40 20 | Apply + 5 volts ± 5%. SAM draws less than 230 mA. I Return Ground for +5 volts. |
| Input Pins | MPU Address and Control | A15 A14 A13 A12 A11 A10 A9 A8 A7 A6 A5 A4 A3 A2 A1 | 36 37 38 39 1 2 3 4 24 23 22 21 19 18 17 | Most Significant Bit. MPU address bits A0-A15. These 16 signals come directly from the MPU and are used to directly address up to 64K memory locations or to indirectly address up to 96K memory locations. (See pages 17 and 18 for memory maps). Each input is approximately equivalent to one low power Schottky load. Least Significant Bit. |
| | | R/W | 15 | MPU READ or WRITE. This signal comes directly from the MPU and is used to enable writing to the SAM control register, dynamic RAM (via WE), and to enable device select #0. |
| | | Oscin | 5 | Apply 14.31818* MHz crystal and 2.5–30 pF trimmer to ground. See page 12. |
| | VDG Control | DA0 HS VCIk | 9 7 | Display Address DA0. The primary function of this pin is to input the least significant bit of a 16-bit video display address. The more significant 15-bits are outputs from an internal 15-bit counter which is clocked by DA0. The secondary function of this pin is to indirectly input the logic level of the VDG "FS" (field synchronization pulse) for vertical video address updating. Horizontal Synchronization. The primary function of this pin is to detect the falling edge of VDG "HS" pulse in order to initiate eight dynamic RAM refresh cycles. The secondary function is to reset up to 4 least significant bits of the internal video address counter. VDG Clock. The primary function of this pin is to output a 3.579545 MHz square wave** to the |
| | | | | VDG "Clk" pin. The secondary function resets the SAM when this VClk pin is pulled to logic "0" level, acting as an input . |
| | | Oscout | 6 | Apply 1.5 kΩ resistor to 14.31818* MHz crystal and 33 pF capacitor to ground. See page 12. |
| | Device Selects | S2 S1 | 25 26 27 | Most Significant Bit (Device Select Bits). The binary value of S2, S1, S0 selects one of eight "chunks" of MPU address space (numbers 0 through 7). Varying in length, these "chunks" provide efficient memory mapping for ROMs, RAMs, Input/Output devices, and MPU Vectors. (Requires 74LS 138-type demultiplexer). Least Significant Bit. |
| | MPU | E | 14 | E (Enable Clock) "E" and "Q" are 90° out of phase and are both used as MPU clocks for the MC6809E. For the MC6800 and MC6801E, only "E" is used. "E" is also used for many MC6800 peripheral chips. |
| Ë | - 3 | Q | 13 | Q (Quadrature Clock). |
| Output Pins | RAM Address | Z7† Z6† Z5† Z4† Z3† Z2† Z1† Z0† | 35 34 33 32 31 30 29 28 | Most Significant Bit First, the least significant address bits from the MPU or "VDG" are presented to Z0–Z5 (4K x 1 RAMs) or Z0–Z6 (16K x 1 RAMs) or Z0–Z7 (64K x 1 RAMs). Next, the most significant address bits from the MPU or "VDG" are presented to Z0–Z5 (4K x 1 RAMs) or Z0–Z6 (16K x 1 RAMs) or Z0–Z7 (64K x 1 RAMs). Note that for 4K x 1 and 16K x 1 RAMs, Z7 (Pin 35) is not needed for address information. Therefore, Pin 35 is used for a second row address select which is labeled (RAS1). Least Significant Bit. |
| | RAM Control | RAS1† | 35 12 | Row Address Strobe One. This pulse strobes the least significant 6,7 or 8 address bits into dynamic RAMs in Bank #1. Row Address Strobe Zero. This pulse strobes the least significant 6,7 or 8 address bits into dynamic RAMs in Bank #0. |
| | " 3 | CAS† | 11 | Column Address Strobe. This pulse strobes the most significant 6,7 or 8 address bits into dynamic RAMs. |
| L | L | WE† | 10 | Write Enable. When low, this pulse enables the MPU to write into dynamic RAM. |

^{*14.31818} MHz is 4 times 3.579545 MHz television color subcarrier. Other frequencies may be used. (See page 12.)

**When VDG and SAM are not yet synchronized the "square wave" will stretch (see page 10.)

† Due to fast transitions, ferrite beads in series with these outputs may be necessary to avoid high frequency (~ 60 MHz) resonances.

FIGURE 2 - TIMING WAVEFORMS for MPU RATE = SLOW

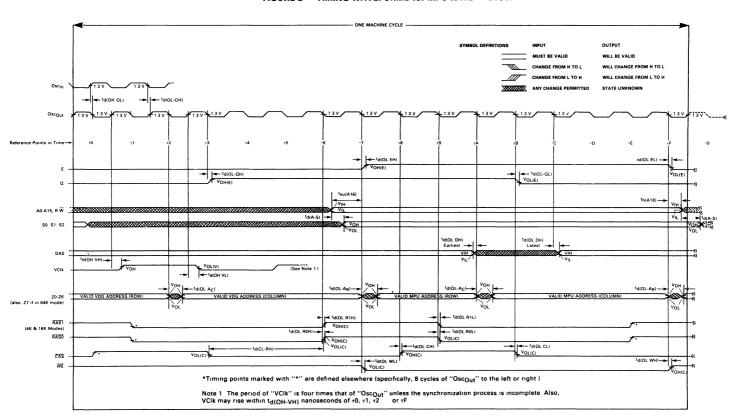
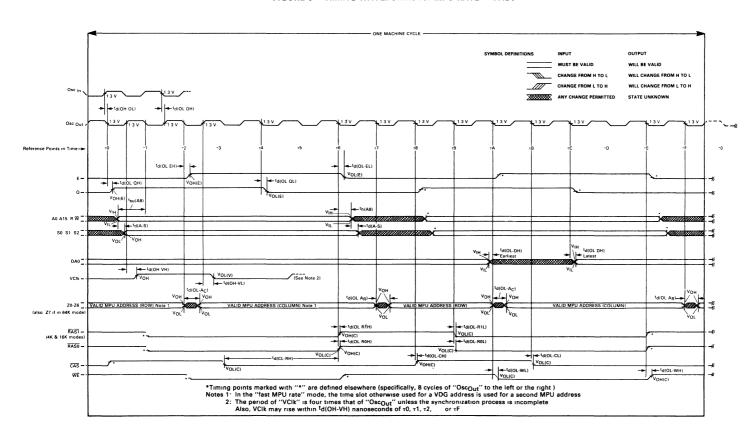
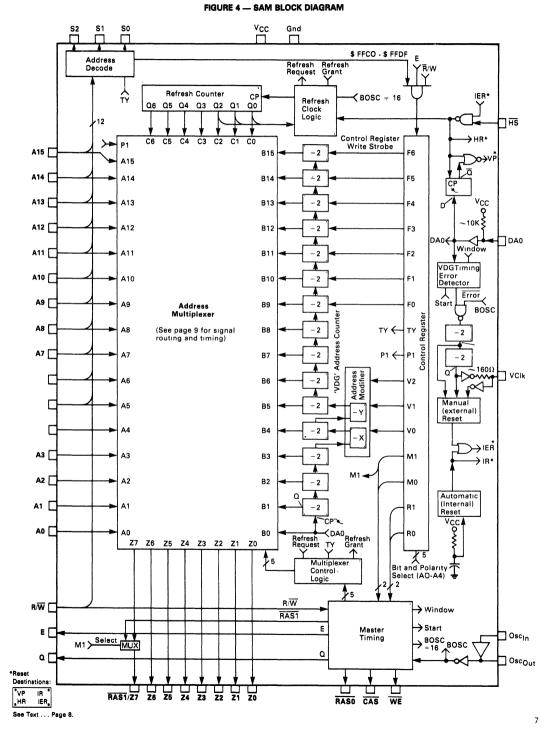


FIGURE 3— TIMING WAVEFORMS for MPU RATE = FAST





4-636

SAM BLOCK DIAGRAM DESCRIPTION

MPU Addresses (A0 - A15):

These 16 signals come directly from the MPU and are used to directly address up to 64K memory locations (K = 1024) or to indirectly address up to 96K memory locations, by using a paging bit "P" (see pages 17 and 18 for memory maps.) Each input is approximately equivalent to one low power Schottky load.

VDG Address Counter (B0 - B15):

These 16 signals are derived from one input (DA0) which is the least significant bit of the VDG address. Most of the counter is simply binary. However, to duplicate the various addressing modes of the MC6847 VDG, ADDRESS MODIFIER logic is used. Selected by three VDG mode bits (V2, V1, and V0) from the SAM CONTROL REGISTER, eight address modifications are obtained as shown in Figure 5.

Also, notice that bits B9-B15 may be loaded from bits F0-F6 from the CONTROL REGISTER. This allows the starting address of the VDG display to be offset (in $\frac{1}{2}$ K increments) from \$0000 to \$FFFF† . B9-B15 are loaded when a VERTICAL PRE-LOAD(VP) pulse is generated. VP goes active (high) when $\overline{\text{HS}}$ from the VDG rises if DA0 is high (or a high impedance.) This condition should occur only while the TV electron beam is in vertical blanking and is simply implemented by connecting $\overline{\text{FS}}$ and $\overline{\text{MS}}$ together on the MC6847. The VP pulse also clears bits B1 – B8.

Finally, a HORIZONTAL RESET (HR) pulse may also affect the counter by clearing bits B1 – B3 or B1 – B4 when HS from the VDG is LOW (see Figure 5.) The HR pulse should occur only while the TV electron beam is in horizontal blanking.

In summary, DA0 clocks the VDG ADDRESS COUNTER; HR initializes the horizontal portion and VP initializes the vertical portion of the VDG ADDRESS COUNTER.

REFresh Address Counter (C0 - C6):

A seven bit binary counter with outputs labeled C0 - C6 supplies bursts of eight* sequential addresses triggered by a HS high to low transition. Thus, while the TV electron beam is in horizontal blanking, eight sequential addresses are accessed. Likewise, the next eight addresses are accessed during the next horizontal blanking period, etc. In this manner, all 128 addresses are refreshed in less than 1.1 milliseconds.

Address Multiplexer:

Occupying a large portion of the block diagram in Figure 4, is the address multiplexer which outputs bits Z0-Z7 (as addresses to dynamic RAM's.) Inputs to the address multiplexer include the VDG address (80 – B15) the REFresh address (C0-C6) and the MPU address (A0 – A15) or (A0 – A14 plus one paging bit "P".) The paging bit "P" is one bit in the SAM CONTROL REGISTER that is used in place of A15 when memory map Type #0 is selected (via the SAM CONTROL REGISTER "TY" bit.)

Figure 6 shows which inputs are routed to Z0 – Z7 and **when** the routing occurs relative to one SAM machine cycle. Notice that Z7 and RAS1 share the same pin. Z7 is selected if "M1" in the SAM CONTROL REGISTER IS HIGH (Memory size = 64K.)

Address Decode:

At the top left of Figure 4, is the Address Decode block. Outputs S2, S1, and S0 form a three bit encoded binary word(S). Thus S may be one of eight values (0 through 7) with each value representing a different range of MPU addresses. (To enable peripheral ROM's or I/O, decode the S2, S1, and S0 bits into eight seperate signals by using a 74LS138, 74LS155 or 74LS156. Notice that S2, S1, and S0 are **not** gated with any timing signals such as E or Q.)

Along with the A5 – A15 inputs is the MEMORY MAP Type bit (TY.) This bit is soft-programmable (as are all 16 bits in the SAM CONTROL REGISTER,) and selects one of two memory maps. Memory map #0 is intended to be used in systems that are primarily ROM based. Whereas, memory map #1 is intended for a primarily RAM based system with 64K contiguous RAM locations (minus 256 locations.) The various meanings of S2, S1, S0 are tabulated in Figure 16 (page 19) and again on pages 17 and 18.

In addition to S2, S1, and S0 outputs is a decode of \$FFCO through \$FFDF which, when gated with E and \overline{R}/W , results in the write strobe for the SAM CONTROL REGISTER.

SAM Control Register

As shown in Figure 4, the CONTROL REGISTER has 16 "outputs":

 VDG Addressing Modes:
 V2, V1, V0
 MPU Rate:
 R1, R0

 VDG Address OFFset:
 F6, F5, F4, F3, F2, F1, F0
 Memory Size (RAM):
 M1, M0

32K Page Switch: P Memory Map TYpe:

When the SAM is reset (see page 10,) all 16 bits are cleared. To set any one of these 16 bits, the MPU simply writes to a unique** odd address (within \$FFC1 through \$FFDF.) To clear any one of these 16 bits, the MPU

- * If $\overline{\rm HS}$ is held low longer than 8 μ s, then the number of sequential addresses in one refresh "BURST" is proportional to the time interval during which $\overline{\rm HS}$ is low.
- ** See pages 17 or 18 for specific addresses.
- † In this document, the "\$" symbol always preceeds hexidecimal characters

ΤY

simply writes to a unique** even address (within \$FFCO through \$FFDE.) Note that the data on the MPU data bus is irrevelant.

Inputs to the control register include A4, A3, A2, A1 (which are used to select which one of 16 bits is to be cleared or set), A0 (which determines the polarity ... clear or set,) and R/W, E and \$FFCO - \$FFDF (which restrict the method, timing and addresses for changing one of the 16 bits.) For more detailed descriptions of the purposes of the 16 control bits, refer to related sections in the BLOCK DIAGRAM DESCRIPTION (pages 8 through 12) and the PROGRAMMING GUIDE (pages 14 through 18).

FIGURE 5 — VDG ADDRESS MODIFIER

| | Mode | | Division | Variables | Bits Cleared by HS (low) |
|----|------|----|----------|-----------|--------------------------|
| V2 | V1 | V0 | х | Υ | |
| 0 | 0 | 0 | 1 | 12 | B1-B4 |
| 0 | 0 | 1 | 3 | 1 | B1-B3 |
| 0 | 1 | 0 | 1 | 3 | B1-B4 |
| 0 | 1 | 1 | 2 | 1 | B1-B3 |
| 1 | 0 | 0 | 1 | 2 | B1-B4 |
| 1 | 0 | 1 | 1 . | 1 | B1-B3 |
| 1 | 1 | 0 | 1 | 1 | B1-B4 |
| 1 | 1 | 1 | 1 | 1 | None (DMA MODE) |

FIGURE 6 — SIGNAL ROUTING for ADDRESS MULTIPLEXER

| Men | Memory Size | | Signal | Row/Column | Signals Routed to Z0-Z7 | | | | | | | Timing | |
|----------|-------------|----|--------|------------|-------------------------|------------|------------|-----|------------|-----|------------|--------|---------------|
| | M1 | Mo | Source | | Z 7 | Z 6 | Z 5 | Z4 | Z 3 | Z2 | Z 1 | ZO | (Figure 2) |
| 4K | 0 | 0 | MPU | ROW | * | A6 | A5 | A4 | A3 | A2 | A1 | A0 | T7-TA |
| | | | | COL | * | L | A11 | A10 | A9 | A8 | A7 | A6 | TA-TF |
| | | | VDG | ROW | * | В6 | B5 | B4 | В3 | B2 | B1 | B0 | TF-T2 |
| | | | | COL | * | L | B11 | B10 | В9 | B8 | B7 | В6 | T2-T7 |
| | | | REF | ROW | * | C6 | C5 | C4 | С3 | C2 | C1 | CO | TF-T2 |
| | | | | COL | * | L | L | L | L | L | L | L | T2-T7 |
| 16K | 0 | 1 | MPU | ROW | * | A6 | A5 | A4 | A3 | A2 | A1 | A0 | T7-TA |
| | | | | COL | * | A13 | A12 | A11 | A10 | A9 | A8 | A7 | TA-TF |
| | | | VDG | ROW | * | В6 | B5 | B4 | В3 | B2 | B1 | ВО | TF-T2 |
| | | | | COL | * | B13 | B12 | B11 | B10 | В9 | B8 | В7 | T2-T7 |
| | | | REF | ROW | * | C6 | C5 | C4 | С3 | C2 | C1 | CO | TF-T2 |
| | | | | COL | * | L | L | L | L | L | L | L | T2-T7 |
| 64K (dy | namic) | | MPU | ROW | A7 | A6 | A5 | A4 | А3 | A2 | A1 | A0 | T7-TA |
| | 1 | 0 | | COL | P/A15*** | A14 | A13 | A12 | A11 | A10 | A9 | A8 | TA-TF |
| | | | VDG | ROW | B7 | В6 | B5 | B4 | В3 | B2 | B1 | B0 | TF-T2 |
| | | | | COL | B15 | B14 | B13 | B12 | B11 | B10 | В9 | B8 | T2-T7 |
| | | | REF | ROW | L | C6 | C5 | C4 | C3 | C2 | C1 | C0 | TF-T2 |
| | | | | COL | L | L | L | L | L | L | L | L | T2-T7 |
| 64K (sta | tic) | | MPU | ROW | A7 | A6 | A5 | A4 | А3 | A2 | A1 | A0 | T7- T9 |
| | 1 | 1 | | COL | P/A15*** | A14 | A13 | A12 | A11 | A10 | A9 | A8 | T9-TF |
| | | | VDG | ROW | B7 | В6 | B5 | B4 | В3 | B2 | B1 | BO | TF-T1 |
| | | | | COL | B15 | B14 | B13 | B12 | B11 | B10 | B9 | B8 | T1 -T7 |
| | | | REF | ROW | L | C6 | C5 | C4 | СЗ | C2 | C1 | CO | TF-T1 |
| | | | | COL | L | L | L | L | L | L | L | L | T1 -T7 |

Notes: "L" implies logical LOW level.

^{**} See pages 17 or 18 for specific addresses.

^{*27} functions as RAS1 and its level is address dependent. For example, when using two banks of 16K x 1 RAMs, RAS0 is active for addresses \$0000 to \$3FFF and RAS1 is active for addresses \$4000 to \$7FFF.

***If Map TYpe = 0, then page bit "P" is the output (otherwise A15).

Internal Reset

By lowering V_{CC} below 0.6 volts for at least one millisecond, a **complete** SAM reset is initiated and is completed within 500 nanoseconds after V_{CC} rises above 4.25 volts.

NOTE: In some applications, (for example, multiple "VDG-RAM" systems controlled by a single MPU) multiple SAM ICs can be synchronized as follows:

- Drive all SAM's from one external oscillator.
- Stop external oscillator.
- Lower V_{CC} below 0.6 volts for at least 1.0 millisecond.
- Raise V_{CC} to 5.0 volts.
- Start external oscillator.
- Wait at least 500 nanoseconds.

Now, the "E" clocks from all SAM's should be in-phase.

External Reset

When the VCIk pin on SAM is forced below 0.8 volts for at least eight cycles of "oscillator-out", the SAM becomes partially reset. That is, all bits in the SAM control register are cleared. However, signals such as RAS, CAS, WE, E or Q are not stopped (as they are with an internal reset), since the SAM must maintain dynamic RAM refresh even during this external reset period.

Figure 7 shows how VClk can be pulled low through diode D1 when node "A" is low.* When node "A" is high, only the backbiased capacitance of diode D1 loads the 3.58 MHz on VClk. Diode D2 helps discharge C1 (Power-on-Reset capacitor) when power is turned off. Diode D3 allows the MPU reset time constant R2C2 to be greater than the SAM reset time constant. Thereby, ensuring **release** of the SAM reset **prior to** attempting to program the SAM control register.

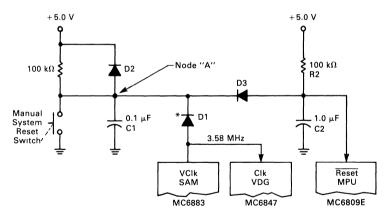


FIGURE 7 — EXTERNAL RESET CIRCUITRY

VDG Synchronization

In order for the VDG and MPU to share the same dynamic RAM (see page 13,) the VDG clock must be stopped until the VDG data fetch and MPU data fetch are synchronized as shown in Figure 12. Once synchronized, the VDG clock resumes its 3.579545 MHz rate and is not stopped again unless an extreme temperature change (or SAM reset) occurs. When stopped, the VDG clock remains stopped for no more than 32 Osc_{Out} cycles (approximately 2 microseconds.)

In the block diagram in Figure 4, DA0 enters a block labeled VDG Timing Error Detector. If DA0 rises **between** time reference points** τ_A and τ_C , then Error is high and VCIk is the result of dividing BOSC (Buffered Osc_{Out} \approx 14 MHz) by four. However, if DA0 rises **outside** the time Window τ_A to τ_C , then Error goes LOW and the VDG stops. A START pulse at time reference point τ_B (center of Window) restarts the VDG . . . properly synchronized.

^{*}Use a diode with sufficiently low forward voltage drop to meet VIL requirement at VCIk

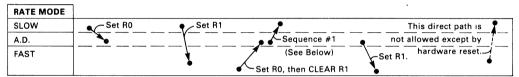
^{**}See timing diagrams on page 5 and 6.

Changing the MPU Rate (by changing SAM control register bits R0, R1).

Two bits in the SAM control register determine the period of both "E" and "Q" MPU clocks. Three rate modes are implemented as follows:

| RATE MODE | R1 | RO | |
|----------------------|----|-----------|---|
| SLOW | 0 | 0 | The frequency of "E" (and "Q") is f crystal - 16. This rate mode is automatically selected when the SAM is reset. Note that system timing is least critical in this "SLOW" rate mode. |
| A.D. (Address Dep | • | 1 ent) | The frequency of "E" (and "Q") is either f crystal $-$ 16 or f crystal $-$ 8, depending on the address the MPU is presenting. |
| FAST | 1 | x | The frequency of "E" (and "Q") is f crystal - 8. This is accomplished by stealing the time that is normally used for VDG/REFRESH, and using this time for the MPU. Note: Neither VDG display nor dynamic RAM refresh are available in the "FAST" rate mode. (Both are available in SLOW and A.D. rate modes). |

When changing between any two of the three rate modes, the following procedures must be followed to ensure that MPU timing specifications are met:



May be ANY address from \$0000 to \$7FFF.

7D 00 00 TST #\$0000 . . . Synchronizes STA instruction to write during T2-TG (See Figure #8).*

21 00 BRN 00

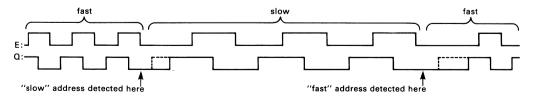
B7 FF D6 STA #\$FFD6 . . . Clears bit R0

Changing the MPU Rate (In Address Dependent Mode)

When the SAM control register bits "R1", and "R0" are programmed to "0" and "1", respectively, the Address Dependent Rate Mode is selected. In this mode, the \div 16 MPU rate is automatically used when addressing within \$0000 to \$7FFF* or \$FF00 to \$FF1F ranges. Otherwise the - 8 MPU rate is automatically used. (Refer to Figure 8 for sample "E" and "Q" waveforms yielding - 8 to - 16 and - 16 to - 8 rate changes). This mode often nearly doubles the MPU throughput while still providing transparent VDG and dynamic, RAM refresh functions. For example, since much of the MPU's time may be spent performing internal MPU functions (address = \$FFFF)**, accessing ROM (address = \$8000 to \$FEFF) or accessing I/O (address = \$FF50 — \$FF5F), the faster f crystal \div 8 MPU rate may be used much of the time.

Note The VDG operates normally when using the SLOW or A.D rate modes. However, in the FAST rate mode, the VDG is not allowed access to the dynamic RAM.

FIGURE 8 — RATE CHANGE E AND Q WAVEFORMS



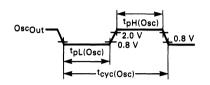
^{*}When using Memory Map 0, addresses \$0000 to \$7FFF may access Dynamic RAM

^{*}Note: "TST" instruction affects MC6809E condition code register

^{**}The MC6809 outputs \$FFFF on A0-A15 when no other valid addresses are being presented

Oscillator

In Figure 4, an amplifier between Osc_{in} and Osc_{Out} provides the gain for oscillation (using a crystal as shown in Figure 9.) Alternately, Pin 5 (Osc_{in}) may be grounded while Pin 6 (Osc_{Out}) may be driven at low-power Schottky levels as shown in Figure 10. Also, see V_{IH}, V_{IL} on page 2.



| | AC Specifications* | | | | | | |
|----------------------|--------------------|-----|------|-------|--|--|--|
| | Max | Тур | Min | Units | | | |
| tpH(Osc) | | 30 | 22 | ns | | | |
| t _{pL(Osc)} | _ | 30 | 22 | ns | | | |
| tcyc(Osc) | _ | 70 | 62.4 | ns | | | |

FIGURE 9 - CRYSTAL OSCILLATOR

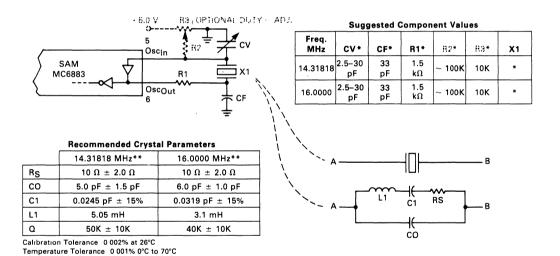
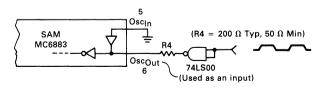


FIGURE 10 — TTL CLOCK INPUT



^{*}Optimum values depend on characteristics of the crystal (X1). For many applications, VClk must be 3.579545 MHz ± 50 Hz! Hence, OscOut must be made similarly "drift resistant" (by balancing temperature coefficients of X1, CV, CF, R1, R2 and R3).

^{**}Specifically cut for MC6883 are International Crystal Manufacturing, Inc. Crystals (#167568 for 14.31818 MHz or #167569 for 16.0 MHz). However, other crystals may be used

THEORY OF OPERATION

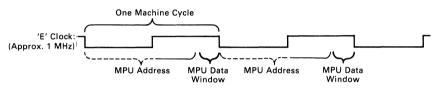
Video or No Video

Although the MC6883 may be used as a dynamic RAM controller **without** a video display*, most applications are likely to include a MC6847 video display generator (VDG). Therefore, this document emphasizes MC6883 with MC6847 systems.

Shared RAM (with interleaved DMA)

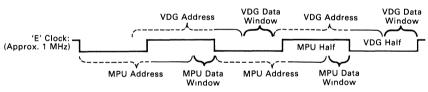
To minimize the number of RAM and interface chips, both the MPU and VDG share common dynamic RAM. Yet, the use of common RAM creates an apparent difficulty. That is, the MPU and VDG must both access the RAM without contention. This difficulty is overcome by taking advantage of the timing and architecture of Motorola MPU's (MC6800, MC6801E, MC6809E, MC68000). Specifically, all MPU accesses of external memory always occur in the latter half of the machine cycle, as shown below:

FIGURE 11 - MOTOROLA MPU TIMING



Similarly, the MC6847 (non-interlaced) VDG transfers a data byte in a half machine cycle (E or Φ 2). Thus, when properly positioned, VDG and MPU RAM accesses interleave without contention as shown below:

FIGURE 12 - MOTOROLA MPU WITH VDG TIMING



This Interleaved Direct Memory Access (IDMA) is synchronized via the MC6883 by centering the VDG data window half-way between MPU data windows.**

The result is a shared RAM system without MPU/VDG RAM access contention, with both MPU and VDG running uninterrupted at normal operating speed, each transparent to the other.

RAM Refresh

Dynamic RAM refresh is accomplished by accessing eight*** sequential addresses every 64*** microseconds until 128 consecutive addresses have been accessed. To avoid RAM access contention between REFRESH and MPU, each of the 128 refresh accesses occupies the "VDG half" of the interleaved DMA (IDMA). Furthermore, refresh accesses occur only during the television retrace period (at which time the VDG doesn't need to access RAM).

In summary, the VDG, MPU and MC6883's Refresh Counter all transparently access the common dynamic RAM without contention or interruption.

Why IDMA?

Use of the interleaved direct memory access results in fast modification to variable portions of display RAM, by the MPU, without any distracting flashes on the screen (due to RAM access contention.) In addition, the MPU is not slowed down nor stopped by the MC6883; thereby, assuring accurate software timing loops without costly additional hardware timers. Furthermore, additional hardware and software to give "access permission" to the MPU is eliminated since the MPU may access RAM at any time.

^{*} Only 1 pin, (DA0) out of 40 pins is dedicated to the video display

^{**} See VDG synchronization (page 10) for more detail.

^{***} When not using a MC6847, HS may be wired low for continuous transparent refresh

"Systems On Silicon" Concept

Total Timing

For most applications, the SAM can supply complete system timing from its on-chip precision 14.31818 MHz oscillator. This includes buffered MPU clocks (E and Q), VDG clock, color subcarrier (3.58 MHz), row address select (RAS), column address select (CAS) and write enable (WE).

Total Address Decode

For most applications, the SAM plus a "1 of 8 decoder" chip completely decodes I/O, ROM and RAM chip selects without wasting memory address space and without needlessly chopping-up contiguous address space. Chip selects are positioned in address space to allow three types of memory (RAM, local ROM and cartridge ROM) independent room for growth. For example, RAM may grow from address \$0000-up, cartridge ROM may grow from address \$FEFF-down and local ROM may grow from \$FBFF-down. Alternately, if the application requires minimum ROM and maximum contiguous RAM, a second choice of two memory maps places RAM from \$0000 to \$FEFF. (See pages 17 and 18.)

In both memory maps all I/O, MPU vectors, SAM control registers, and some reserved address spaces are efficiently contained between addresses \$FF00 and \$FFFF.

How Much RAM?

Using nine SAM pins (Z0 - Z7 and RAS0) the following combinations require no additional address logic.

FIGURE 13 - RAM CONFIGURATIONS

| | Address: | Chip Select: | |
|------------|----------------|--------------|--|
| MSB | LSB | | |
| | Z5Z4Z3Z2Z1Z0 | RAS0 | |
| | Z5Z4Z3Z2Z1Z0 | RAS1 (=Z7) | Caracteristics of 4K x 8 (like MCM4027's) |
| | Z6Z5Z4Z3Z2Z1Z0 | RAS0 | ĺ |
| | Z6Z5Z4Z3Z2Z1Z0 | RAS1 (= Z7) | One or two banks of 16K x 8 (like MCM4116's) |
| Z 7 | Z6Z5Z4Z3Z2Z1Z0 | RAS0 | One bank of 64K x 8 (like MCM6665's) |

PROGRAMMING GUIDE

SAM — Programmability

The SAM contains a 16-bit control register which allows the MC6809E to program the SAM for the following options:

| VDG Addressing Mode | 3-bits |
|---------------------|---------|
| VDG Address Offset | 7-bits |
| 32K Page Switch | . 1-bit |
| MPU Rate | 2-bits |
| Memory Size | 2-bits |
| Man Tyne | |

Note that when the SAM is **reset** by first applying power or by manual hardware reset,† all control register bits are **cleared** (to a logic "0").

VDG Addressing Mode

Three bits (V2, V1, V0) control the sequence of DISPLAY ADDRESSES generated by the SAM (which are used to scan dynamic RAM for video information). For example, if you wish to display Dynamic RAM data as INTERNAL ALPHANUMERICS VIDEO, you should program‡ the MC6847 for the INTERNAL ALPHANUMERICS MODE and CLEAR BITS V2, V1 and V0 in the SAM. The table on the following page summarizes the available modes:

[†] See Figure 7 for manual reset circuit.

[‡] Typically, part of a PIA (MC6821) at location \$FF22 is used to control MC6847 modes. (See MC6847 Data Sheet.)

| | | MC6847 Mode | | | | | | SAM Mode | | |
|------------------------|-----|-------------|-----|--------------|-----|----|----|----------|--|--|
| Mode Type | G/Ā | GM2 | GM1 | GMØ EXT/Ī | css | V2 | V1 | Vo | | |
| Internal Alphanumerics | 0 | X | X | 0 | Х | 0 | 0 | 0 | | |
| External Alphanumerics | 0 | Х | Х | 1 | х | 0 | 0 | 0 | | |
| OSemigraphics — 4 | 0 | Х | X | 0 | х | 0 | 0 | 0 | | |
| Semigraphics — 6 | 0 | X | Х | 1 | Х | 0 | 0 | 0 | | |
| Semigraphics — 8* | 0 | х | х | 0 | х | 0 | 1 | 0 | | |
| Semigraphics — 12* | 0 | х | х | 0 | Х | 1 | 0 | 0 | | |
| Semigraphics — 24* | 0 | Х | х | 0 | Х | 1 | 1 | 0 | | |
| Full Graphics — 1C | 1 | 0 | 0 | 0 | Х | 0 | 0 | 1 | | |
| Full Graphics — 1R | 1 | 0 | 0 | 1 | Х | 0 | 0 | 1 | | |
| Full Graphics — 2C | 1 | 0 | 1 | 0 | Х | 0 | 1 | 0 | | |
| Full Graphics — 2R | 1 | 0 | 1 | 1 | Х | 0 | 1 | 1 | | |
| Full Graphics — 3C | 1 | 1 | 0 | 0 | Х | 1 | 0 | 0 | | |
| Fuil Graphics — 3R | 1 | 1 | 0 | 1 | X | 1 | 0 | 1 | | |
| Full Graphics — 6C | 1 | 1 | 1 | 0 | х | 1 | 1 | 0 | | |
| Full Graphics — 6R | 1 | 1 | 1 | 1 | Х | 1 | 1 | 0 | | |
| Direct Memory Access† | × | X | Х | х | X | 1 | 1 | 1 | | |

^{*}S8, S12, & S24 modes are not described in the MC6847 Data Sheet. See appendix "A".

VDG Address Offset

Seven bits (F6, F5, F4, F3, F2, F1 and F0) determine the **Starting Address** for the video display. The "Starting Address" is defined as "the address corresponding to data displayed in the **Upper Left** corner of the TV screen". The "Starting Address" is shown below in binary:



Note that the "Starting Address" may be placed anywhere within the 64K address space with a resolution of ½K (the size of one alphanumeric page).

The F6-F0 bits take effect during the TV vertical synchronization pulse (i.e., when FS from MC6847 is low).

Page Switch

One bit (P1) is used "in place of" A15 from the MC6809E in order to refer access within \$0000-\$7FFF to one of two 32K byte pages of RAM. If the system does not use more than 32K bytes of RAM, P1 can be ignored.**

[†]DMA is identical to 6R except as shown in Figure 5 on page 9

^{**}When using 4K x 1 RAMS, two banks of eight IC's are allowed. This accounts for Addresses \$0000-1FFF. Also, this same RAM can be addressed at \$2000-\$3FFF, \$4000-\$5FFF and \$6000-\$7FFF

MPU Rate

Two bits (R1, R0) control the clock rate to the MC6809E MPU. The options are:

| RATE (FREQUENCY OF "E" CLOCK) | R1 | RO |
|---|-----|----|
| 0.9 MHz (Crystal Frequency ÷ 16) Slow | 0 | 0 |
| 0.9/1.8 MHz (Address Dependent Rate) | 0 | 1 |
| 1.8 MHz (Crystal Frequency - 8) Fast | 1 | х |
| (Typical Crystal Frequency = 14.31818 M | Hz) | L |

In the "address dependent rate" mode, accesses to \$0000-\$7FFF and \$FF00-\$FF1F are slowed to 0.9 MHz (crystal frequency \div 16) and all other addresses are accessed at 1.8 MHz (crystal frequency \div 8.)

Memory Size

Two bits (M1 and M0) determine RAM memory size. The options are:

| SIZE | M1 | Мо |
|--|----|----|
| One or two banks of 4K × 1 dynamic RAMs | 0 | 0 |
| One or two banks of 16K × 1 dynamic RAMs | 0 | 1 |
| One bank of 64K × 1 dynamic RAMs | 1 | 0 |
| Up to 64K static RAM* | 1 | 1 |

^{*}Requires a latch for demultiplexing the RAM address

IMPORTANT!

Note: Be sure to program the SAM for the correct memory size **before** using RAM (i.e., for a subroutine stack).

Map Type

One bit (TY) is used to select between two memory map configurations.

Refer to pages 17, 18 and 19 for details. When using Map Type "TY = 1", only the "Slow" MPU rate may be used. Future versions of the SAM may allow use of all rates.

Writing To The SAM Control Register

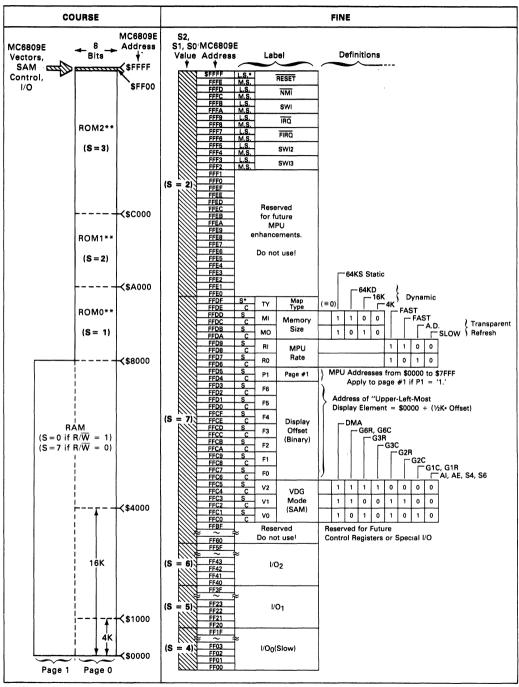
Any bit in the control register (CR) may be set by writing to a specific unique address. Each bit has two unique addresses . . . writing to the **even** # address **clears** the bit and writing to the **odd** # address **sets** the bit. (Data on the data bus is irrelevant in this procedure.) The specific addresses are tabulated on pages 17 and 18.

If desired, a short routine may be written to program the SAM CR "a word at a time". For example, the following routine copies "B" bits from "A" register to SAM CR addresses beginning with address "X".

| SAM1 | 46 | | ROR | Α |
|------|----|----|-----|-----------|
| | 24 | 06 | BCC | SAM2 |
| | 30 | 01 | INX | (LEAX1,X) |
| | A7 | 80 | STA | O,X+ |
| | 20 | 02 | BRA | SAM3 |
| SAM2 | Α7 | 81 | STA | O,X++ |
| SAM3 | 5A | | DEC | В |
| 1 | 26 | F2 | BNE | SAM1 |
| | 39 | | RTS | |



FIGURE 14 - MEMORY MAP (TYPE #0)



*Note:

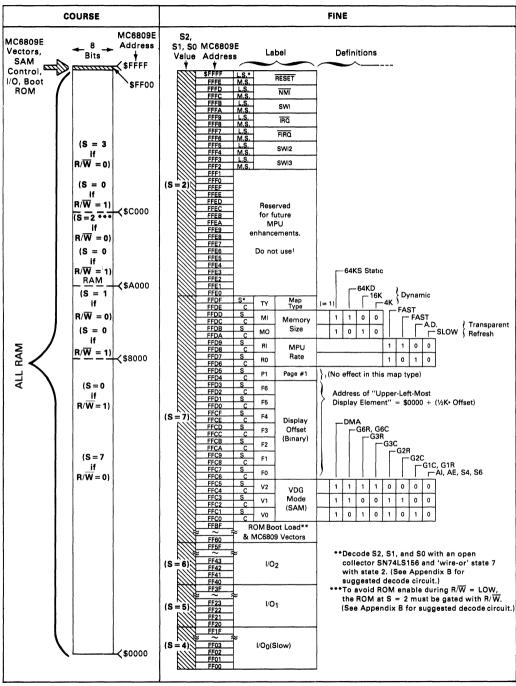
**May also be RAM

 $[\]begin{array}{ll} \text{M.S.} \equiv \text{Most Significant} & \text{S} \equiv \text{Set Bit} \\ \text{L.S.} \equiv \text{Least Significant} & \text{C} \equiv \text{Clear Bit} \end{array} \right\}$

S = Set Bit (All bits are cleared when SAM is reset.)

S = Device Select value = 4 x S2 + 2 x S1 + 1 x S0

FIGURE 15 - MEMORY MAP (TYPE #1)



*Note:

M.S. = Most Significant
L.S. = Least Significant
C = Clear Bit (All bits are cleared when SAM is reset.)

L.S. = Least Significant C = Clear Bit (All Dits are cleared when SAM is respectively)

S = Device Select value = 4 x S2 + 2 x S1 + 1 x S0

FIGURE 16 — MEMORY ALLOCATION TABLE (Also, see the memory MAPs on pages 17 and 18.)

Type # 0: (Primarily for ROM based systems)

| Address Range | S = 4(S2) + 2 (S1) + S0 S Value | Intended Use |
|----------------|--|---|
| \$FFF2 to FFFF | 2 | MC6809E Vectors: Reset , NMI, SWI, IRQ, FIRQ, SWI2, SWI3. |
| FFE0 to FFF1 | 2 | Reserved for future MPU enhancements. |
| FFC0 to FFDF | 7 | SAM Control Register: V0, - V2, F0 - F6, P, R0, R1, M0, M1, TY. |
| FF60 to FFBF | 7 | Reserved for future control register enhancements. |
| FF40 to FF5F | 6 | I/O2: Input/Output (PIAs, ACIAs, etc.) To subdivide, use A0 – A4. |
| FF20 to FF3F | 5 | I/O1: Input/Output (PIAs, ACIAs, etc.) To subdivide, use A0 – A4. |
| FF00 to FF1F | 4 | I/O ₀ : Input/Output (PIAs, ACIAs, etc.) To subdivide, use A0 – A4. |
| C000 to FEFF | 3 | ROM2: 16K addresses. External cartridge ROM*. |
| A000 to BFFF | 2 | ROM1: 8K addresses. Internal ROM*. Note that MC6809E vector addresses select this ROM*. |
| 8000 to 9FFF | 1 1 | ROM0: 8K addresses. Internal ROM*. |
| 0000 to 7FFF | $0 \text{ if } R/\overline{W} = 1 \\ 7 \text{ if } R/\overline{W} = 0$ | RAM: 32K addresses. RAM shared by MPU and VDG. |

^{*}Not restricted to ROM. For example, RAM or I/O may be used here.

Type # 1: (Primarily for RAM based systems)

| Address Range | S = 4(S2) + 2 (S1) + S0 S Value | Intended Use |
|----------------|---------------------------------------|---|
| \$FFF2 to FFFF | 2 | MC6809E Vectors: Reset, NMI, SWI, IRQ, FIRQ, SWI2, SWI3. |
| FFE0 to FFF1 | . 2 | Reserved for future MPU enhancements. |
| FFC0 to FFDF | 7 | SAM Control Register: V0 - V2, F0 - F6, P, R0, R1, M0, M1, TY. |
| FF60 to FFBF | 7 | Small ROM: Boot load program and initial MC6809 vectors. |
| FF40 to FF5F | 6 | I/O2: Input/Output (PIAs, ACIAs, etc.) To subdivide, use A0-A4. |
| FF20 to FF3F | 5 | I/O1: Input/Output (PIAs, ACIAs, etc.) To subdivide, use A0 – A4. |
| FF00 to FF1F | 4 ' | I/O ₀ : Input/Output (PIAs, ACIAs, etc.) To subdivide, use A2 – A4. |
| 0000 to FEFF | 0 if R/W = 1 | RAM: 64K(-256) addresses, shared by MPU and VDG. |
| | | (If $R/\overline{W} = 0$ then $S = 3$ for \$C000-\$FEFF; $S = 2$ for \$A000-\$BFFF; $S = 1$ for |
| | | \$8000-\$9FFF and S = 7 for \$0000-\$7FFF. |
| | | |

APPENDIX A

VDG/SAM Video Display System Offers 3 New Modes

by Paul Fletcher

There are three new modes created when the VDG and SAM are used together in a video display system. These modes offer alphanumeric compatibility with 8 color low-to-high resolution graphics, 64H*64V, 64H*96V, 64H*192V. The new modes S8, S12, and S24 are created by placing the VDG in the Alpha Internal mode and having the SAM in a 2K, 3K or 6K full color graphics mode. In all modes the VDG's S/A and Inv. pins are connected to data bits DD7 and DD6 to allow switching on the fly between Alpha and Semigraphics and between inverted and non-inverted alpha. This method is used in most VDG systems to obtain maximum flexibility.

The three modes divide the standard 8*12 dot box used by the VDG for the standard alpha and semi-graphics modes into eight 4*3 dot boxes for the S8 mode, twelve 4*2 dot boxes for the S12 mode, and twenty-four 4*1 dot boxes for the S24 mode. Figure 17 shows the arrangement of these boxes. One byte is needed to control two horizontally consecutive boxes. It therefore takes four bytes for the S8, six bytes for the S12, and 12 bytes for the S24 mode to control the entire 8*12 dot box. These two horizontally consecutive boxes have four combinations of luminance controlled by bits B0 – B3. For convenience of the standard semi-graph of the standard semi-graph of the standard semi-graph of the standard semi-graph of the standard semi-graph of the standard semi-graph of the S12 mode.

ience B2 should be made equal to B0 and B3 should be made equal to B1. This eliminates a screen placement problem which would cause other codes to change patterns when moved vertically on the screen. The illuminated boxes can be one of eight colors which are controlled by B4 - B6 (see Figure 18). The bytes needed to control all the boxes in the 8*12 dot box must be spaced 32 address spaces apart in the display RAM because of the addressing scheme orginally used in the VDG and duplicated by the SAM. This means to place an alphanumeric character on the TV screen it requires 4, 6, or 12 bytes depending on the mode used. These bytes are placed 32 memory locations apart in the display RAM (see Figure 18). This multiple byte format allows the mixing of character rows of different characters in the same 8*12 dot box creating new characters and symbols. It also allows overlining and underlining in eight colors by switching to semigraphics at the correct time.

These new modes optimize the memory versus screen density tradeoffs for RF performance on color TVs. This could make them the most versatile of all the modes depending on the users creativity and the software sophistication.

APPENDIX B Memory Decode for "MAP TYPE = 1"

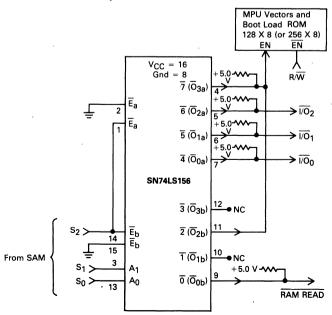
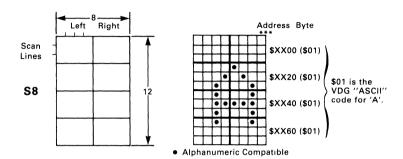
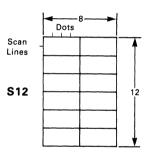


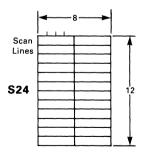
FIGURE 17 — DISPLAY MODES S8, S12, S24 Bit/Visible Dot Correlation





| Left | Right *, | * |
|--------|----------|---------------|
| Red | Red | \$XX00 (\$BF) |
| Blue | Off | \$XX20 (\$AA) |
| Off | Green | \$XX40 (\$85) |
| Orange | Orange | \$XX60 (\$FF) |
| Off | Off | \$XX80 (\$80) |
| Yellow | Yellow | \$XXA0 (\$9F) |

Options: One of 8 colors for
 L or R or both. Off = Black



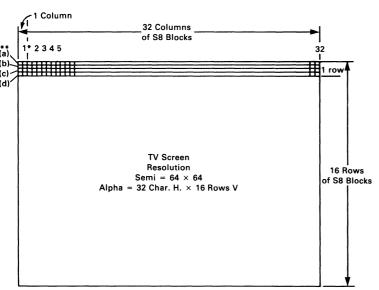
| | ** | •* |
|----------|-------|---------------------------|
| Blue | Blue | \$XX00 (\$AF) |
| Black | Black | \$XX20 (\$80) |
| Black | Black | \$XX40 (\$80) VDG |
| • • | | \$XX60 (\$14) -Code for T |
| • | • | [2VV80 (218) |
| • | • | \$XXA0 (\$18) } |
| HH | • | \$XXC0 (\$18) VDG |
| — | - | \$XXE0 (\$18) > Code |
| 1 | • | \$X100 (\$18) \ for X |
| 1 | 1 | \$X120 (\$18)) |
| Black | Black | \$X140 (\$80) ´ |
| Green | Green | \$X160 (\$8F) |

- Underline, Overline
- Mix Character Dot Rows

^{***} Characters will always remain in standard VDG positions.

FIGURE 18 — S8 DISPLAY FORMAT EXAMPLES - 8 . (1)* **B7** ВО L3 Semi (a)** L1 L0 Х Х Inv Alpha L1 L0 (b) S8 12 Extra **ASCII Code** (c) L1 L0 (d) L1 LO ·1 Column 32 Columns

| | | | , | | | | | | |
|----|----|----|----|---------|----------|-------|-----|---------|-------|
| LX | C2 | C1 | СО | Color | B3,B1 | B2,B0 | | 4 | |
| 0 | х | х | х | Black | 0 | 0 | = | Off | Off |
| 1 | 0 | 0 | 0 | Green | | | | L r | |
| 1 | 0 | 0 | 1 | Yellow | 0 | 1 | = | Off | Color |
| 1 | 0 | 1 | 0 | Blue | | | | | |
| 1 | 0 | 1 | 1 | Red | 1 | 0 | = | Color | Off |
| 1 | 1 | 0 | 0 | Buff | | | | | |
| 1 | 1 | 0 | 1 | Cyan | 1 | 1 | = | Color | |
| 1 | 1 | 1 | 0 | Magenta | <u> </u> | | | | l |
| 1 | 1 | 1 | 1 | Orange | | C0 C | 14- | maru Ma | _ |



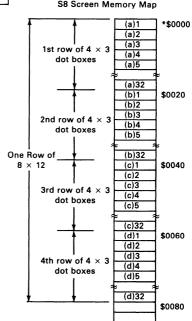
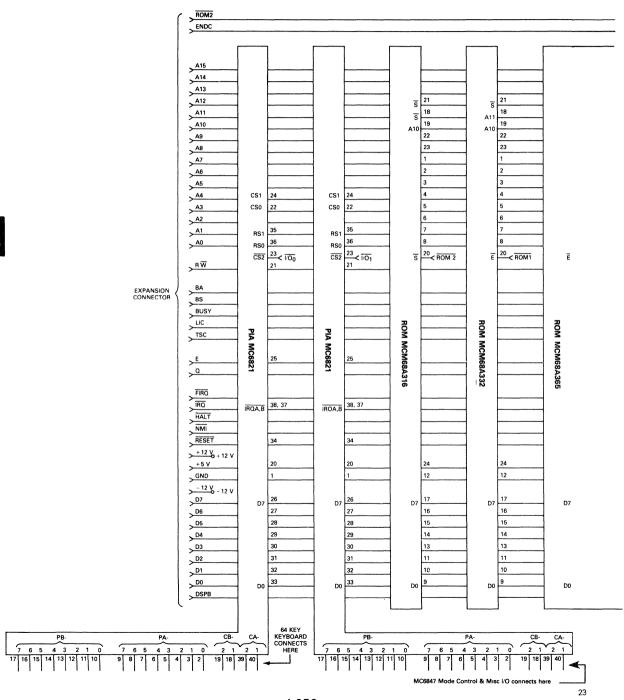
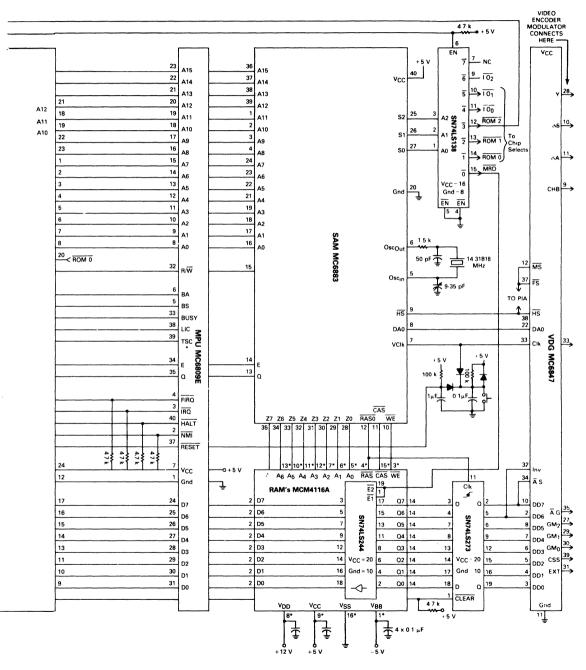


FIGURE 19 -- EXAMPLE of MC



83 and MC6847 COMPUTER



^{*}This pin number on 8 different RAM chips is connected to this point

FIGURE 20 — EQUIVALENT OF OSCILLATOR INPUT AND OUTPUT

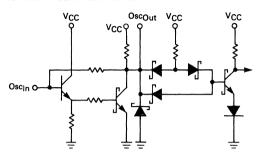


FIGURE 21 - DA0 INPUT

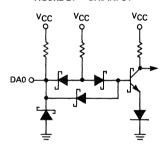


FIGURE 22 — VCIk INPUT/OUTPUT

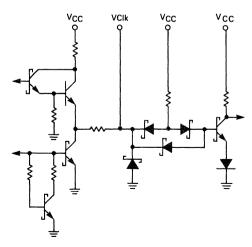


FIGURE 23 - E AND Q OUTPUTS

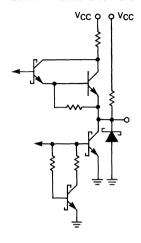


FIGURE 24 — TYPICAL INPUT

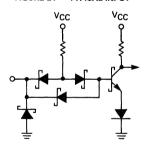
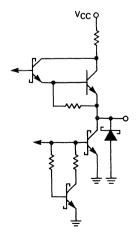


FIGURE 25 — TYPICAL OUTPUT





NON-INVERTING QUAD THREE-STATE BUS TRANSCEIVER

This quad three-state bus transceiver features both excellent MOS or MPU compatibility, due to its high impedance PNP transistor input, and high-speed operation made possible by the use of Schottky diode clamping. Both the -48 mA driver and -20 mA receiver outputs are short-circuit protected and employ three-state enabling inputs.

The device is useful as a bus extender in systems employing the M6800 family or other comparable MPU devices. The maximum input current of 200 μA at any of the device input pins assures proper operation despite the limited drive capability of the MPU clip. The inputs are also protected with Schottky-barrier diode clamps to suppress excessive undershoot voltages.

Propagation delay times for the driver portion are 17 ns maximum while the receiver portion runs 17 ns. The MC8T28 is identical to the NE8T28 and it operates from a single +5 V supply.

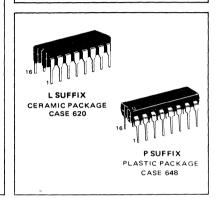
- High Impedance Inputs
- Single Power Supply
- High Speed Schottky Technology
- Three-State Drivers and Receivers
- Compatible with M6800 Family Microprocessor
- Non-Inverting

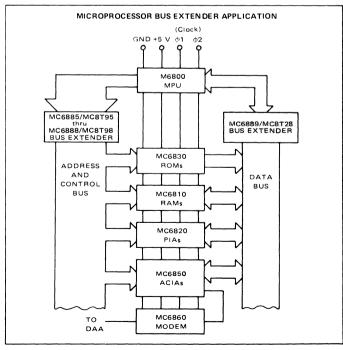
MC6889 MC8T28

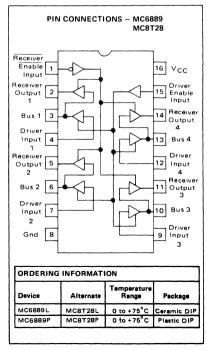
This device may be ordered under either of the above type numbers.

NON-INVERTING BUS TRANSCEIVER

MONOLITHIC SCHOTTKY INTEGRATED CIRCUITS







MAXIMUM RATINGS (T_A = 25°C unless otherwise noted.)

| Rating | Symbol | Value | Unit |
|--|------------------|-------------|------|
| Power Supply Voltage | Vcc | 8.0 | Vdc |
| Input Voltage | VI | 5.5 | Vdc |
| Junction Temperature Ceramic Package Plastic Package | TJ | 175 150 | °c |
| Operating Ambient Temperature Range | TA | 0 to +75 | °C |
| Storage Temperature Range | T _{stg} | -65 to +150 | °c |

ELECTRICAL CHARACTERISTICS (4.75 V < V_{CC} < 5.25 V and 0°C < T_A < 75°C unless otherwise noted.)

| Characteristic | Symbol | Mın | Тур | Max | Unit |
|---|---------------------|-----|------------|---------|----------|
| Input Current - Low Logic State | | | | | |
| (Receiver Enable Input, VIL(RE) = 0.4 V) | IL(RE) | _ | \ _ | -200 | μА |
| (Driver Enable Input, VIL(DE) = 0.4 V) | IL(DE) | _ | - | -200 | |
| (Driver Input, VIL(D) = 0 4 V) | IIL(D) | - | - | -200 | |
| (Bus (Receiver) Input, VIL(B) = 0.4 V) | IL(B) | - | _ | -200 | |
| Input Disabled Current — Low Logic State | IL(D) DIS | | | | |
| (Driver Input, $V_{IL(D)} = 0.4 V$) | 112(0) 013 | _ | _ | - 25 | μΑ |
| Input Current-High Logic State | | | | | • |
| (Receiver Enable Input, VIH(RE) = 5 25 V) | IH(RE) | _ | _ | 25 | μА |
| (Driver Enable Input, VIH(DE) = 5 25 V) | IH(DE) | _ | _ | 25 | |
| (Driver Input, VIH(D) = 5 25 V) | IH(D) | _ | - | 25 | |
| Input Voltage - Low Logic State | | | | | |
| (Receiver Enable Input) | VIL(RE) | _ | \ _ | 0 85 | V |
| (Driver Enable Input | VIL(DE) | _ | _ | 0 85 | |
| (Driver Input) | V _{IL(D)} | _ | - | 0.85 | |
| (Receiver Input) | VIL(B) | _ | _ | 0.85 | |
| Input Voltage — High Logic State | | | | | |
| (Receiver Enable Input) | VIH(RE) | 20 | | _ | V |
| (Driver Enable Input) | VIH(DE) | 20 | ì _ |] _ | • |
| (Driver Input) | | 20 | _ | _ | |
| (Receiver Input) | V _{IH} (D) | 2.0 | } _ | _ | |
| (Receiver Input) | VIH(B) | 2.0 | | _ | |
| Output Voltage - Low Logic State | 1 | | | | |
| (Bus Driver) Output, I _{OL(B)} = 48 mA) | V _{OL} (B) | _ | - | 0.5 | V |
| (Receiver Output, I _{OL(R)} = 20 mA) | V _{OL(R)} | _ | _ | 0.5 | |
| Output Voltage - High Logic State | | | | l | |
| (Bus (Driver) Output, $I_{OH(B)} = -10 \text{ mA}$) | V _{OH(B)} | 2.4 | 3 1 | _ | V |
| (Receiver Output, $I_{OH(R)} = -2.0 \text{ mA}$) | V _{OH(R)} | 2.4 | 3.1 | - | |
| (Receiver Output, $I_{OH(R)} = -100 \mu A$, $V_{CC} = 5.0 \text{ V}$) | 1 | 3.5 | - | - | |
| Output Disabled Leakage Current - High Logic State | | | | · | |
| (Bus Driver) Output, V _{OH(B)} = 2.4 V) | OHL(B) | _ | _ | 100 | μΑ |
| (Receiver Output, VOH(R) = 2.4 V) | OHL(R) | - | - | 100 | , |
| Output Disabled Leakage Current — Low Logic State | | | | | |
| (Bus Output, V _{OL(B)} = 0.5 V) | OLL(B) | _ | l – | -100 | μд |
| (Receiver Output, V _{OL(R)} = 0.5 V) | OLL(R) | _ | _ | -100 | |
| Input Clamp Voltage | | | | | |
| (Driver Enable Input I _{ID(DE)} = -12 mA) | VIC(DE) | - | - | -10 | l v |
| (Receiver Enable Input I _{IC} (RE) = +12 mA) | VIC(RE) | _ | _ | -10 | - |
| (Driver Input I _{IC(D)} = -12 mA) | VIC(D) | - | - | -10 | |
| Output Short-Circuit Current, V _{CC} = 5 25 V (1) | | | | | |
| (Bus (Driver) Output) | IOS(B) | -50 | _ | -150 | mA. |
| (Receiver Output) | IOS(B) | -30 | _ | -75 | |
| Power Supply Current | I _{CC} | _ | | 110 | mA |
| $(V_{CC} = 5.25 \text{ V})$ | | | | | |

⁽¹⁾ Only one output may be short-circuited at a time.

SWITCHING CHARACTERISTICS (Unless otherwise noted, V_{CC} = 5.0 V and T_A = 25°C)

| Characteristic | Symbol | Min | Max | Unit |
|---|--|-----|----------|------|
| Propagation Delay Time—Receiver (C _L = 30 pF) | tPLH(R) tPHL(R) | _ | 17 17 | ns |
| Propagation Delay Time—Driver (C _L = 300 pF) | ^t PLH(D) ^t PHL(D) | _ | 17 17 | ns |
| Propagation Delay Time-Enable (C _L = 30 pF) - Receiver | tPZL(R) tPLZ(R) | - | 23 18 | ns |
| - Driver Enable (C _L 300 pF) | tPZL(D) | _ | 28 23 | |

FIGURE 1 – TEST CIRCUIT AND WAVEFORMS FOR PROPAGATION DELAY FROM BUS (RECEIVER) INPUT TO RECEIVER OUTPUT, $t_{PLH(R)}$ AND $t_{PHL(R)}$

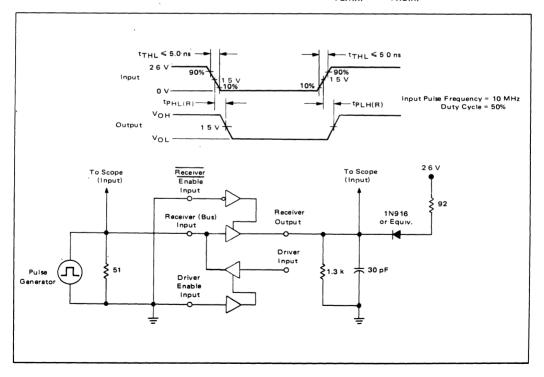


FIGURE 2 – TEST CIRCUIT AND WAVEFORMS FOR PROPAGATION DELAY TIME FROM DRIVER INPUT TO BUS (DRIVER) OUTPUT, tPLH(D) AND tPHL(D)

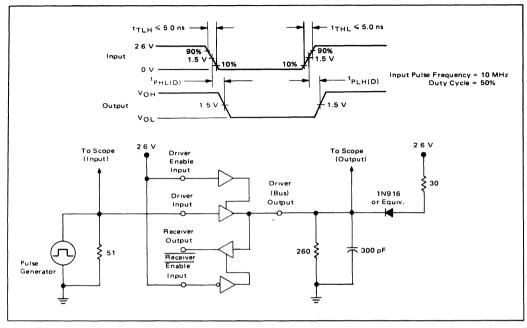


FIGURE 3 – TEST CIRCUIT AND WAVEFORMS FOR PROPAGATION DELAY TIME FROM RECEIVER ENABLE INPUT TO RECEIVER OUTPUT, tplz(RE) AND tpzl(RE)

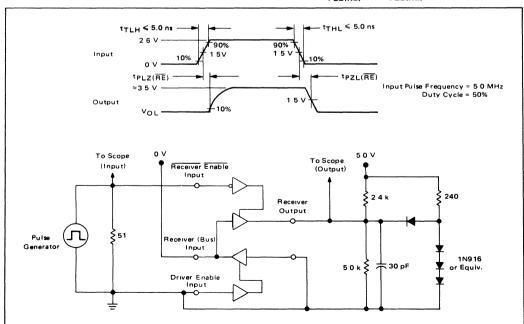


FIGURE 4 – TEST CIRCUIT AND WAVEFORMS FOR PROPAGATION DELAY TIMES FROM DRIVER ENABLE INPUT TO DRIVER (BUS) OUTPUT, tplz(DE) AND tpzl(DE)

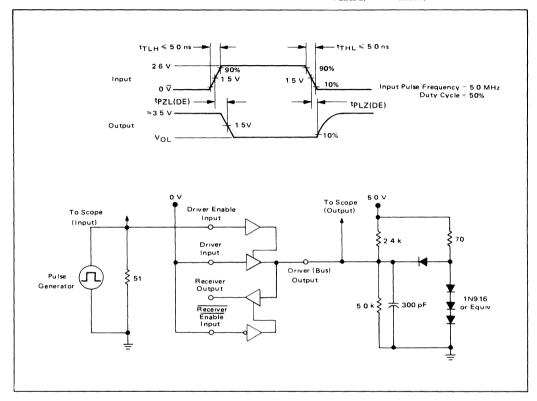
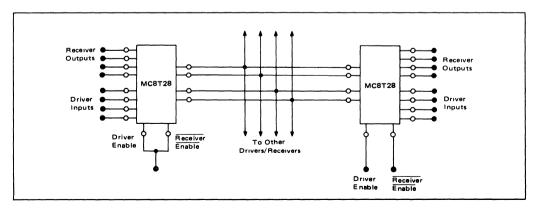
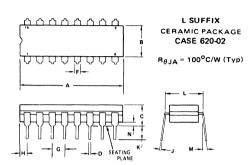


FIGURE 5 - BIDIRECTIONAL BUS APPLICATIONS





NOTES

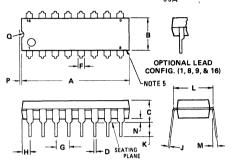
- LEADS WITHIN 0 13 mm (0 005) RADIUS OF TRUE POSITION AT SEATING PLANE
 AT MAXIMUM MATERIAL CONDITION
 2 PKG INDEX NOTCH IN LEAD
- NOTCH IN CERAMIC OR INK DOT 3 DIM "L" TO CENTER OF LEADS WHEN FORMED PARALLEL

| | MILLIN | IETERS | INC | HES | | | |
|-----|--------|--------|-------|---------|--|--|--|
| DIM | MIN | MAX | MIN | MAX | | | |
| Α | 19 05 | 19 81 | 0 750 | 0 780 | | | |
| В | 6 22 | 6 98 | 0 245 | 0 275 | | | |
| C | 4 06 | 5 08 | 0 160 | 0 200 | | | |
| D | 0.38 | 0 51 | 0 015 | 0 020 | | | |
| F | 1 40 | 1 65 | 0 055 | 0 065 | | | |
| G | 2 54 | BSC | 0 100 | | | | |
| Н | 0.51 | 1 14 | 0 020 | 0 045 | | | |
| J | 0 20 | 0 30 | 0 008 | 0 0 1 2 | | | |
| К | 3 18 | 4 06 | 0 125 | 0 160 | | | |
| L | 7 37 | 7 87 | 0 290 | 0 310 | | | |
| M | - | 150 | - | 150 | | | |
| N | 0.51 | 1.02 | 0.020 | 0.040 | | | |

CASE 620-02

P SUFFIX PLASTIC PACKAGE CASE 648-05

 $R_{\theta JA} = 100^{\circ} C/W (Typ)$



NOTES

- 1. LEADS WITHIN 0.13 mm (0.005) RADIUS OF TRUE POSITION AT SEATING PLANE AT MAXIMUM MATERIAL CONDITION.
- 2. DIMENSION "L" TO CENTER OF LEADS WHEN FORMED PARALLEL.
- 3. DIMENSION "B" DOES NOT INCLUDE MOLD FLASH.
- 4. "F" DIMENSION IS FOR FULL LEADS. "HALF" LEADS ARE OPTIONAL AT LEAD POSITIONS 1 8 9 and 16) 5. ROUNDED CORNERS OPTIONAL.

| | MILLIN | ETERS | INC | HES |
|-----|--------|-------|-------|-------|
| DIM | MIN | MAX | MIN | MAX |
| A | 18.80 | 21.34 | 0.740 | 0.840 |
| В | 6.10 | 6.60 | 0.240 | 0.260 |
| C | 4.06 | 5.08 | 0.160 | 0.200 |
| D | 0.38 | 0.53 | 0.015 | 0.021 |
| F | 1.02 | 1.78 | 0.040 | 0.070 |
| G | 2 54 | BSC | 0 100 | BSC |
| H | 0.38 | 2.41 | 0.015 | 0.095 |
| J | 0.20 | 0.38 | 0.008 | 0.015 |
| K | 2.92 | 3.43 | 0.115 | 0.135 |
| L | 7.62 | BSC | 0.300 | BSC |
| M | 00 | 100 | 00 | 100 |
| N | 0.51 | 1.02 | 0.020 | 0.040 |

THERMAL INFORMATION

The maximum power consumption an integrated circuit can tolerate at a given operating ambient temperature, can be found from the equation

$$P_{D(T_A)} = \frac{T_{J(max)} - T_A}{R_{\theta JA}(Typ)}$$

Where $P_{D(T_A)}$ = Power Dissipation allowable at a given operating ambient temperature. This must be greater than

the sum of the products of the supply voltages and supply currents at the worst case operating condition

T_J(max) = Maximum Operating Junction Temperature as listed in the Maximum Ratings Section TA = Maximum Desired Operating Ambient

ROJA(Typ) = Typical Thermal Resistance Junction to Ambient

Temperature



Advance Information

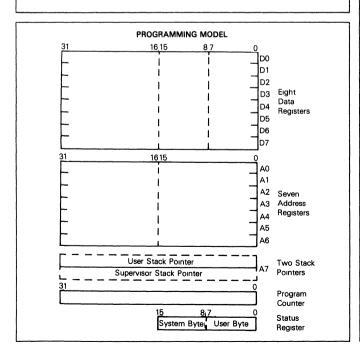
16-BIT MICROPROCESSING UNIT

Advances in semiconductor technology have provided the capability to place on a single silicon chip a microprocessor at least an order of magnitude higher in performance and circuit complexity than has been previously available. The MC68000 is the first of a family of such VLSI microprocessors from Motorola. It combines state-of-the-art technology and advanced circuit design techniques with computer sciences to achieve an architecturally advanced 16-bit microprocessor.

The resources available to the MC68000 user consist of the following.

- 32-Bit Data and Address Registers
- 16 Megabyte Direct Addressing Range
- 56 Powerful Instruction Types
- Operations on Five Main Data Types
- Memory Mapped I/O
- 14 Addressing Modes

As shown in the programming model, the MC68000 offers seventeen 32-bit registers in addition to the 32-bit program counter and a 16-bit status register. The first eight registers (D0-D7) are used as data registers for byte (8-bit), word (16-bit), and long word (32-bit) data operations. The second set of seven registers (A0-A6) and the system stack pointer may be used as software stack pointers and base address registers. In addition, these registers may be used for word and long word address operations. All seventeen registers may be used as index registers.



MC68000L4 (4 MHz) MC68000L6 (6 MHz) MC68000L8 (8 MHz) MC68000L10 (10 MHz)

HMOS

(HIGH-DENSITY, N-CHANNEL, SILICON-GATE DEPLETION LOAD)

16-BIT MICROPROCESSOR



| D4 □ 1 | PIN ASSI | GNMENT |
|--|----------------|-----------------|
| D3 | D4C1 | 64 □ D5 |
| D1C4 61 D8 D0 D5 60 D9 ASC 6 59 D10 UDSC 7 58 D11 LDS B8 57 D12 R/W 9 56 D13 DTACK 10 55 D14 BG 11 54 D15 BGACK 12 53 GND BR 13 52 A23 VCC 14 51 A22 CLK 15 50 A21 GND 16 49 VCC HALT 17 48 A20 RESET 18 47 A19 VMA 19 46 A18 EC 20 45 A17 VPAC 21 44 A16 BERR 22 43 A15 IPLO 25 40 A12 IPLO 25 40 A12 IPLO 25 40 A12 FC2 26 39 A11 FC1 27 38 A10 FC0 28 37 A9 A1C 29 36 A8 | | |
| DO 5 6 D9 AS 6 59 D10 UDS 7 58 D11 LDS 18 57 D12 R/W 9 56 D13 DTACK 10 55 D14 BG 11 54 D15 BGACK 12 53 GND BR 13 52 A23 VCC 14 51 A22 CLK 15 50 A21 GND 16 49 VCC HALT 17 48 A20 RESET 18 47 A19 VMA 19 46 A18 E 20 45 A17 VPA 19 46 A18 E 20 45 A17 VPA 21 44 A16 BERR 22 43 A15 IPL2 23 42 A14 IPL1 24 41 A13 IPL0 25 40 A12 FC2 26 39 A11 FC1 27 38 A10 FC0 28 37 A9 A16 29 36 A8 | D2 C 3 | 62 D7 |
| ASC 6 59 D10 UDSC 7 58 D11 LDSC 8 57 D12 R/WC 9 56 D13 DTACK 10 55 D14 BGC 11 54 D15 BGACK 12 53 GND BR 13 52 A23 VCC 14 51 A22 CLK 15 50 A21 GND 16 49 VCC HALT 17 48 A20 RESET 18 47 A19 VMA 19 46 A18 EC 20 45 A17 VPA 12 1 44 A16 BERR 22 43 A15 IPL2 23 42 A14 IPL1 24 41 A13 IPL0 25 40 A12 FC2 26 39 A11 FC1 27 38 A10 FC0 28 37 A9 A1C 29 36 A8 | D1 C 4 | 61 二 D8 |
| UDS 7 58 D11 LDS 8 57 D12 R/W 9 56 D13 DTACK □10 55 D14 BG □11 54 D15 BGACK □12 53 GND BR □13 52 A23 VCC □14 51 A22 CLK □15 50 A21 GND □16 49 VCC HALT □17 48 □ A20 RESET □18 47 □ A19 VMA □19 46 □ A18 E□20 45 □ A17 VPA □21 44 □ A16 BERR□22 43 □ A15 IPL□23 42 □ A14 IPL□24 41 □ A13 IPL□24 41 □ A13 IPL□25 40 □ A12 FC2□26 39 □ A11 FC1□27 38 □ A10 FC0□28 37 □ A9 A1□29 36 □ A8 | D0 🗖 5 | 60 D9 |
| DS 8 57 D12 | ĀŠ ⊏ 6 | 59 二 D10 |
| R/W 9 56 D13 DTACK 10 55 D14 BG 11 54 D15 BGACK 12 53 GND BR 13 52 A23 VCC 14 51 A22 CLK 15 50 A21 GND 16 49 VCC HALT 17 48 A20 RESET 18 47 A19 VMA 19 46 A18 E 20 45 A17 VPA 21 44 A16 BERR 22 43 A15 IPL 23 42 A14 IPL 24 41 A13 IPL 25 40 A12 FC2 26 39 A11 FC1 27 38 A10 FC0 28 37 A9 A1 29 36 A8 | ŪDS ⊏ 7 | 58 二 D11 |
| DTACK 10 55 D14 BG 11 54 D15 BGACK 12 53 GND BR 13 52 A23 VCC 14 51 A22 CLK 15 50 A21 GND 16 49 VCC HALT 17 48 A20 RESET 18 47 A19 VMA 19 46 A18 EC 20 45 A17 VPA 21 44 A16 BERR 22 43 A15 IPL2 23 42 A14 IPL1 24 41 A13 IPL0 25 40 A12 FC2 26 39 A11 FC1 27 38 A10 FC0 28 37 A9 A1 29 36 A8 | ŪS □8 | 57 🗖 D12 |
| BG 111 54 D15 BGACK □12 53 GND BR □13 52 A23 VCC □14 51 A22 CLK □15 50 A21 GND □16 49 VCC HALT □17 48 A20 RESET □18 47 A19 VMA □19 46 A18 E□ 20 45 A17 VPA □21 44 A16 BERR □22 43 A15 IPL2 □23 42 A14 IPL1 □24 41 A13 IPL0 □25 40 A12 FC2 □26 39 A11 FC1 □27 38 A10 FC0 □28 37 DA9 A1 □29 36 DA8 | R/ ₩⊏ 9 | 56 □ D13 |
| BGACK 12 53 GND BR 13 52 A23 VCC 14 51 A22 CLK 15 50 A21 GND 16 49 VCC HALT 17 48 A20 RESET 18 47 A19 VMA 19 46 A18 EC 20 45 A17 VPA 21 44 A16 BERR 22 43 A15 IPL 23 42 A14 IPL 24 41 A13 IPL 25 40 A12 FC2 26 39 A11 FC1 27 38 A10 FC0 28 37 A9 A1 29 36 A8 | | |
| BR 13 52 A23 VCC 14 51 A22 CLK 15 50 A21 GND 16 49 VCC HALT 17 48 A20 RESET 18 47 A19 VMA 19 46 A18 EC 20 45 A17 VPA 21 44 A16 BERR 22 43 A15 IPL2 23 42 A14 IPL1 24 41 A13 IPL0 25 40 A12 FC2 26 39 A11 FC1 27 38 A10 FC0 28 37 A9 A1 29 36 A8 | | |
| V _{CC} 14 51 A22 CLK 15 50 A21 GND 16 49 V _{CC} HALT 17 48 A20 RESET 18 47 A19 VMA 19 46 A18 EC 20 45 A17 VPA 21 44 A16 BERR 22 43 A15 IPL2 23 42 A14 IPL1 24 41 A13 IPL0 25 40 A12 FC2 26 39 A11 FC1 27 38 A10 FC0 28 37 A9 A1 29 36 A8 | | |
| CLK 15 50 A21 GND 16 49 VCC HALT 17 48 A20 RESET 18 47 A19 VMA 19 46 A18 EC 20 45 A17 VPA 21 44 A16 BERR 22 43 A15 IPL 23 42 A14 IPL 124 41 A13 IPL 025 40 A12 FC2 26 39 A11 FC1 27 38 A10 FC0 28 37 A9 A1 29 36 A8 | | |
| GND 16 49 VCC HALT 17 48 A20 RESET 18 47 A19 VMA 19 46 A18 E 20 45 A17 VPA 21 44 A16 BERR 22 43 A15 IPL 23 42 A14 IPL 24 41 A13 IPL 025 40 A12 FC2 26 39 A11 FC1 27 38 A10 FC0 28 37 A9 A1 29 36 A8 | | |
| HALT 17 48 A20 RESET 18 47 A19 VMA 19 46 A18 EC 20 45 A17 VPA 21 44 A16 BERR 22 43 A15 IPL2 23 42 A14 IPL1 24 41 A13 IPL0 25 40 A12 FC2 26 39 A11 FC1 27 38 A10 FC0 28 37 A9 A1 29 36 A8 | | |
| RESET 18 47 1 A19 VMA 19 46 A18 EC 20 45 A17 VPAC 21 44 A16 BERRC 22 43 A15 IPL2 C23 42 A14 IPL1 C24 41 A13 IPL0 C25 40 A12 FC2 C26 39 A11 FC1 C27 38 A10 FC0 C28 37 A9 A1 C29 36 A8 | | |
| VMA 19 46 A18 E 20 45 A17 VPA 21 44 A16 BERR 22 43 A15 IPL2 23 42 A14 IPL1 24 41 A13 IPL0 25 40 A12 FC2 26 39 A11 FC1 27 38 A10 FC0 28 37 A9 A1 29 36 A8 | | |
| EC 20 45 A17 VPAC 21 44 A16 BERRC 22 43 A15 IPL2 C 23 42 A14 IPL1 C 24 41 A13 IPL0 C 25 40 A12 FC2 C 26 39 A11 FC1 C 27 38 A10 FC0 28 37 A9 A1C 29 36 A8 | | |
| VPA□ 21 | | B |
| BERR 22 43 A15 IPL2 23 42 A14 IPL1 24 41 A13 IPL0 25 40 A12 FC2 26 39 A11 FC1 27 38 A10 FC0 28 37 A9 A1 29 36 A8 | | |
| | | |
| IPL1 | | |
| IPLO 25 40 A12 FC2 26 39 A11 FC1 27 38 A10 FC0 28 37 A9 A1 29 36 A8 | | |
| FC2 26 39 A11 FC1 27 38 A10 FC0 28 37 A9 A1 29 36 A8 | | |
| FC1 27 38 A10 FC0 28 37 A9 A1 29 36 A8 | | |
| FC0 28 37 A9 A1 29 36 A8 | | |
| A1 29 36 A8 | | |
| | | F |
| | A2 30 | 35 A7 |
| A3 31 34 A6 | | |
| A4 32 33 A5 | — T | |
| 33 5 A0 | 7712 | |

MAXIMUM RATINGS

| Rating | Symbol | Value | Unit |
|-----------------------------|------------------|-------------|------|
| Supply Voltage | Vcc | -03 to +70 | ٧ |
| Input Voltage | V _{in} | -03 to +70 | V |
| Operating Temperature Range | TA | 0 to 70 | °C |
| Storage Temperature | T _{stg} | - 55 to 150 | °C |

THERMAL CHARACTERISTICS

| Characteristic | Symbol | Value | Unit |
|--------------------|-------------|-------|------|
| Thermal Resistance | | | |
| Ceramic Package | θ JA | 30 | °C/W |

This device contains circuitry to protect the inputs against damage due to high static voltages or electric fields, however, it is advised that normal precautions be taken to avoid application of any voltage higher than maximum-rated voltages to this high-impedance circuit. Reliability of operation is enhanced if unused inputs are tied to an appropriate logic voltage level (e.g., either VSS or VCC.

(1)

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POWER CONSIDERATIONS

The average chip-junction temperature, T_J, in °C can be obtained from

$$T_J = T_A + (P_D \bullet \theta_{JA})$$

Where

TA = Ambient Temperature, °C

 θ JA = Package Thermal Resistance, Junction-to-Ambient, °C/W

 $P_D = P_{INT} + P_{I/O}$

PINT≡ICC×VCC, Watts - Chip Internal Power

PI/O≡Power Dissipation on Input and Output Pins - User Determined

For most applications PI/O

PINT and can be neglected

An approximate relationship between PD and TJ (if PI/O is neglected) is

$$P_D = K - (T_J + 273 ^{\circ}C)$$

Solving equations 1 and 2 for K gives $K = P_{D} \bullet (T_A + 273^{\circ}C) + \theta_{JA} \bullet P_{D}^{2}$

Where K is a constant pertaining to the particular part. K can be determined from equation 3 by measuring P_D (at equilibrium) for a known T_A . Using this value of K the values of P_D and T_J can be obtained by solving equations (1) and (2) iteratively for any value of T_A .

DC ELECTRICAL CHARACTERISTICS (V_{CC}=5 0 Vdc \pm 5%, V_{SS}=0 Vdc, T_A=0°C to 70°C, See Figures 1, 2, and 3)

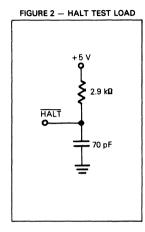
| Characteristic | • | Symbol | Min | Max | Unit |
|---|---|------------------|-----------------------|----------------------|------|
| Input High Voltage | | VIH | 20 | Vcc | V |
| Input Low Voltage | | VIL | V _S S-03 | 0.8 | V |
| Input Leakage Current @ 5 25 V | BERR, BGACK, BR, DTACK, CLK, IPLO-IPL2, VPA HALT, RESET | l _{in} | - | 2 5 20 | μА |
| Three-State (Off State) Input Current @ 2 4 V/0 4 V | AS, A1-A23, D0-D15 FC0-FC2, LDS, R/W, UDS, VMA | ^I TSI | - | 20 | μΑ |
| Output High Voltage ($I_{OH} = -400 \mu A$) | E * AS, A1-A23, BG, D0-D15 FC0-FC2, LDS, R/W, UDS, VMA | Voн | V _{CC} -0 75 | _ | V |
| Output Low Voltage (IOL = 1 6 mA) (IOL = 3 2 mA) (IOL = 35 0 mA) (IOL = 5 3 mA) | HALT A1-A23, BG , FC0-FC2 RESET E, AS , D0-D15, LDS , R/W UDS, VMA | VoL | - - - - | 05 05 05 05 | V |
| Power Dissipation (Clock Frequency = 8 MHz) | | PD | - | 15 | W |
| Capacitance (V _{In} = 0 V, T _A = 25 °C, Frequency = 1 MHz) | | C _{in} | | 10 0 | pF |

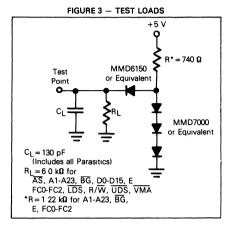
^{*} With external pullup resistor of 470 Ω

FIGURE 1 — RESET TEST LOAD

+5 V
910 Ω

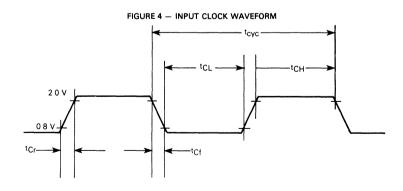
RESET
130 pF





CLOCK TIMING (See Figure 4)

| Characteristic | | 4 MHz MC68000L4 | | 6 MHz MC68000L6 | | 8 MHz .6 MC68000L8 | | 10 MHz MC68000L10 | | Unit |
|------------------------|------------------|--------------------|------------|--------------------|------------|-----------------------|------------|----------------------|------------|------|
| | | Min | Max | Min | Max | Min | Max | Min | Max | |
| Frequency of Operation | F | 2.0 | 40 | 20 | 6.0 | 20 | 80 | 20 | 10.0 | MHz |
| Cycle Time | t _{cyc} | 250 | 500 | 167 | 500 | 125 | 500 | 100 | 500 | ns |
| Clock Pulse Width | tCL tCH | 115 115 | 250 250 | 75 75 | 250 250 | 55 55 | 250 250 | 45 45 | 250 250 | ns |
| Rise and Fall Times | tCr tCf | _ | 10 10 | _ | 10 10 | - | 10 10 | _ | 10 10 | ns |



AC ELECTRICAL SPECIFICATIONS ($V_{CC} = 5$ 0 Vdc $\pm 5\%$, $V_{SS} = 0$ Vdc, $T_A = 0$ °C to 70°C, See Figures 5 and 6)

| | RICAL SPECIFICATIONS(V _{CC} =50 Vdc ±5%,) | 4 MHz | | | | | 1Hz | 10 1 | | | |
|------------------|---|--------------------|-----|----------------|-----|--------------|----------|----------|-----|-------|---------|
| Number | Characteristic | Symbol | | 800L4 | | 300L6 | | 300L8 | | 00L10 | Unit |
| | | | Min | Max | Min | Max | Min | Max | Min | Max | |
| 1 | Clock Period | tcyc | 250 | 500 | 167 | 500 | 125 | 500 | 100 | 500 | ns |
| 2 | Clock Width Low | tCL | 115 | 250 | 75 | 250 | 55 | 250 | 45 | 250 | ns |
| 3 | Clock Width High | tCH | 115 | 250 | 75 | 250 | 55 | 250 | 45 | 250 | ns |
| 4 | Clock Fall Time | tCf | _ | 10 | _ | 10 | _ | 10 | _ | 10 | ns |
| 5 | Clock Rise Time | tCr | - | 10 | - | 10 | _ | 10 | - | 10 | ns |
| 6 | Clock Low to Address | tCLAV | | 90 | - | 80 | _ | 70 | _ | 55 | ns |
| 6A | Clock High to FC Valid | tCHFCV | _ | 90 | _ | 80 | _ | 70 | _ | 60 | ns |
| 7 | Clock High to Address Data High Impedance (Maximum) | tCHAZx | _ | 120 | - | 100 | - | 80 | - | 70 | ns |
| 8 | Clock High to Address/FC Invalid (Minimum) | ^t CHAZn | 0 | _ | 0 | | 0 | - | 0 | _ | ns |
| 91 | Clock High to AS, DS Low (Maximum) | †CHSLx | _ | 80 | - | 70 | - | 60 | - | 55 | ns |
| 10 | Clock High to AS, DS Low (Minimum) | ^t CHSLn | 0 | _ | 0 | _ | 0 | | 0 | - | ns |
| 112 | Address to AS, DS (Read) Low/AS Write | tAVSL | 55 | _ | 35 | _ | 30 | - | 20 | | ns |
| 11A ² | FC Valid to AS, DS, (Read) Low/AS Write | tFCVSL | 80 | - | 70 | - | 60 | - | 50 | - | ns |
| 121 | Clock Low to AS, DS High | tCLSH | _ | 90 | - | 80 | - | 70 | _ | 55 | ns |
| 132 | AS, DS High to Address/FC Invalid | tSHAZ | 60 | - | 40 | - | 30 | _ | 20 | - | ns |
| 142, 5 | AS, DS Width Low (Read)/AS Write | tSL | 535 | - | 337 | _ | 240 | _ | 195 | - | ns |
| 14A ² | DS Width Low (Write) | _ | 285 | _ | 170 | _ | 115 | _ | 95 | _ | ns |
| 152 | AS, DS Width High | ^t SH | 285 | _ | 180 | _ | 150 | _ | 105 | _ | ns |
| 16 | Clock High to AS, DS High Impedance | tCHSZ | _ | 120 | _ | 100 | - | 80 | _ | 70 | ns |
| 172 | AS, DS High to R/W High | tSHRH | 60 | _ | 50 | _ | 40 | _ | 20 | _ | ns |
| 181 | Clock High to R/W High (Maximum) | tCHRHx | - | 90 | _ | 80 | _ | 70 | _ | 60 | ns |
| 19 | Clock High to R/W High (Minimum) | ^t CHRHn | 0 | _ | 0 | _ | 0 | _ | 0 | _ | ns |
| 201 | Clock High to R/W Low | tCHRL | _ | 90 | _ | 80 | _ | 70 | _ | 60 | ns |
| 212 | Address Valid to R/W Low | tAVRL | 45 | _ | 25 | _ | 20 | _ | 0 | _ | ns |
| 21A2 | FC Valid to R/W Low | tFCVRL | 80 | _ | 70 | _ | 60 | _ | 50 | _ | ns |
| 222 | R/W Low to DS Low (Write) | tRLSL | 200 | _ | 140 | - | 80 | _ | 50 | | ns |
| 23 | Clock Low to Data Out Valid | tCLDO | | 90 | _ | 80 | _ | 70 | _ | 55 | ns |
| 252 | DS High to Data Out Invalid | tSHDO | 60 | _ | 40 | _ | 30 | _ | 20 | _ | ns |
| 262 | Data Out Valid to DS Low (Write) | tDOSL | 55 | _ | 35 | _ | 30 | _ | 20 | _ | ns |
| 276 | Data In to Clock Low (Setup Time) | tDICL | 30 | _ | 25 | | 15 | | 15 | | ns |
| 282 | AS, DS High to DTACK High | †SHDAH | 0 | 240 | 0 | 160 | 0 | 120 | 0 | 90 | ns |
| 29 | DS High to Data Invalid (Hold Time) | tSHDI | 0 | _ | 0 | _ | 0 | _ | 0 | _ | ns |
| 30 | AS, DS High to BERR High | tSHBEH | 0 | - | 0 | _ | 0 | _ | 0 | _ | ns |
| 312, 6 | DTACK Low to Data In (Setup Time) | tDALDI | | 180 | _ | 120 | | 90 | | 65 | ns |
| 32 | HALT and RESET Input Transition Time | tRHrf | 0 | 200 | 0 | 200 | 0 | 200 | 0 | 200 | ns |
| 33 | Clock High to BG Low | tCHGL | _ | 90 | _ | 80 | _ | 70 | | 60 | ns |
| 34 | Clock High to BG High | tCHGH | _ | 90 | _ | 80 | <u> </u> | 70 | _ | 60 | ns |
| 35 | BR Low to BG Low | †BRLGL | 15 | 3.0 | 15 | 30 | 15 | 30 | 15 | 3.0 | Clk Per |
| 36 | BR High to BG High | tBRHGH | 15 | 30 | 15 | 30 | 15 | 30 | 15 | 30 | Clk Per |
| 37 | BGACK Low to BG High | tGALGH | 15 | 30 | 15 | 30 | 15 | 30 | 1.5 | 30 | Clk Per |
| 38 | BG Low to Bus High Impedance (With AS High) | †GLZ | - | 120 | - | 100 | - | 80 | | 70 | ns |
| 39 | BG Width High | tGH | 15 | - 120 | 15 | - | 15 | - | 15 | - | Clk Per |
| 46 | BGACK Width | †BGL | 15 | _ | 15 | _ | 15 | | 15 | _ | Clk Per |
| 476 | Asynchronous Input Setup Time | tASI | 30 | - | 25 | _ | 20 | _ | 20 | | ns |
| 48 | BERR Low to DTACK Low (Note 3) | †BELDAL | 50 | - | 50 | - | 50 | | 50 | | ns |
| 53 | Data Hold from Clock High | tCHDO | 0 | - | 0 | - | 0 | <u> </u> | 0 | | ns |
| 55 | R/W to Data Bus Impedance Change | tRLDO | 55 | - | 35 | - | 30 | _ | 20 | | ns |
| | | | | | | | | | | | |

NOTES

- 1 For a loading capacitance of less than or equal to 500 picofarads, subtract 5 nanoseconds from the values given in these columns 2 Actual value depends on clock period
- 3 If #47 is satisfied for both DTACK and BERR, #48 may be 0 ns
- 4 After V_{CC} has been applied for 100 ms
- 5 For T6E, BF4, and R9M mask sets #14 and #14A are one clock period less than the given number
- 6 If the asynchronous setup time (#47) requirements are satisfied, the DTACK low-to-data setup time (#31) requirement can be ignored. The data must only satisfy the data-in to clock-low setup time (#27) for the following cycle.

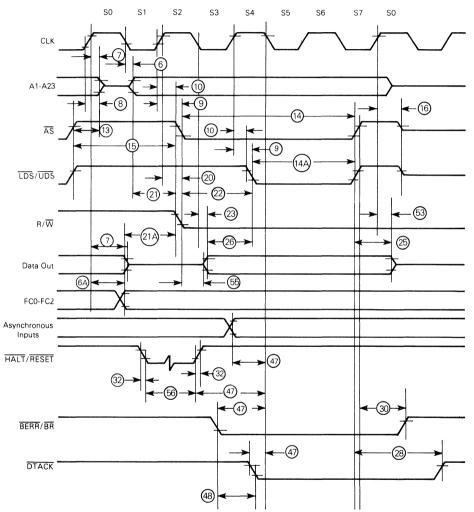
S1 S2 S3 S4 S5 S6 S7 CLK A1-A23 14 ĀS LDS/UDS R/\overline{W} FC0-FC2 Asynchronous Inputs (Note 1) HALT/RESET BERR/BR (Note 2) 48) DTACK Data In

FIGURE 5 - READ CYCLE TIMING

NOTES

- 1 Setup time for the asynchronous inputs BGACK, IPLO-IPL2, and VPA guarantees their recognition at the next falling edge of the clock
- 2 BR need fall at this time only in order to insure being recognized at the end of this bus cycle
- 3 Timing measurements are referenced to and from a low voltage of 0.8 volts and a high voltage of 2.0 volts, unless otherwise noted

FIGURE 6 - WRITE CYCLE TIMING



NOTE Timing measurements are referenced to and from a low voltage of 0.8 volts and a high voltage of 2.0 volts, unless otherwise noted

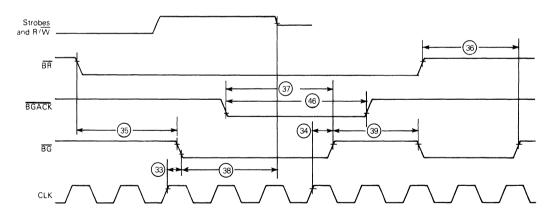
MC68000L4•MC68000L6•MC68000L8•MC68000L10

AC ELECTRICAL SPECIFICATIONS — BUS ARBITRATION(V_{CC}=5 0 Vdc \pm 5%, V_{SS}=0 Vdc, T_A=0°C to 70°C, See Figure 7)

| Number | Characteristic | Symbol | | | 6 MHz MC68000L6 | | 8 MHz MC68000L8 | | 10 MHz MC68000L10 | | Unit |
|--------|---|--------|-----|-----|--------------------|-----|--------------------|-----|----------------------|-----|---------|
| | | | Min | Max | Min | Max | Min | Max | Min | Max | |
| 33 | Clock High to BG Low | tCHGL | - | 90 | _ | 80 | _ | 70 | - | 60 | ns |
| 34 | Clock High to BG High | tCHGH | 1 | 90 | | 80 | 1 | 70 | - | 60 | ns |
| 35 | BR Low to BG Low | †BRLGL | 15 | 35 | 15 | 35 | 15 | 35 | 15 | 35 | Clk Per |
| 36 | BR High to BG High | †BRHGH | 15 | 3 0 | 15 | 30 | 15 | 30 | 15 | 30 | Clk Per |
| 37 | BGACK Low to BG High | tGALGH | 15 | 3 0 | 15 | 30 | 15 | 3 0 | 15 | 30 | Clk Per |
| 38 | BG Low to Bus High Impedance (with AS High) | tGLZ | _ | 120 | _ | 100 | - | 80 | - | 70 | ns |
| 39 | BG Width High | tGH | 15 | _ | 15 | _ | 15 | _ | 15 | _ | Clk Per |
| 46 | BGACK Width | †BGL | 15 | - | 15 | | 15 | - | 15 | _ | Clk Per |

FIGURE 7 - AC ELECTRICAL WAVEFORMS - BUS ARBITRATION

These waveforms should only be referenced in regard to the edge-to-edge measurement of the timing specifications. They are not intended as a functional description of the input and output signals. Refer to other functional descriptions and their related diagrams for device operation.



NOTES

- 1 Setup time for the asynchronous inputs BERR, BGACK, BR, DTACK, IPLO-IPL2, and VPA guarantees their recognition at the next falling edge of the clock
- 2 Waveform measurements for all inputs and outputs are specified at logic high=20 volts, logic low=08 volts

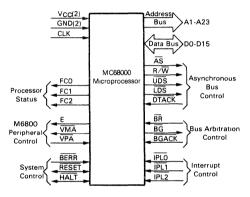
SIGNAL DESCRIPTION

The following paragraphs contain a brief description of the input and output signals. A discussion of bus operation during the various machine cycles and operations is also given

SIGNAL DESCRIPTION

The input and output signals can be functionally organized into the groups shown in Figure 8. The following paragraphs provide a brief description of the signals and also a reference (if applicable) to other paragraphs that contain more detail about the function being performed.

FIGURE 8 - INPUT AND OUTPUT SIGNALS



ADDRESS BUS (A1 THROUGH A23). This 23-bit, unidirectional, three-state bus is capable of addressing 8 megawords of data. It provides the address for bus operation during all cycles except interrupt cycles. During interrupt cycles, address lines A1, A2, and A3 provide information about what level interrupt is being serviced while address lines A4 through A23 are all set to a logic high

DATA BUS (D0 THROUGH D15). This 16-bit, bidirectional, three-state bus is the general purpose data path. It can transfer and accept data in either word or byte length During an interrupt acknowledge cycle, an external device supplies the vector number on data lines D0-D7.

ASYNCHRONOUS BUS CONTROL. Asynchronous data transfers are handled using the following control signals: address strobe, read/write, upper and lower data strobes, and data transfer acknowledge. These signals are explained in the following paragraphs.

Address Strobe (\overline{AS}) . This signal indicates that there is a valid address on the address bus.

Read/Write (R/\overline{W}). This signal defines the data bus transfer as a read or write cycle. The R/\overline{W} signal also works in conjunction with the upper and lower data strobes as explained in the following paragraph.

Upper And Lower Data Strobes ($\overline{\text{UDS}}$, $\overline{\text{LDS}}$). These signals control the data on the data bus, as shown in Table 1 When the R/\overline{W} line is high, the processor will read from the data bus as indicated. When the R/\overline{W} line is low, the processor will write to the data bus as shown

TABLE 1 - DATA STROBE CONTROL OF DATA BUS

| UDS | LDS | R/W | D8-D15 | D0-D7 |
|------|------|------|-------------------------|--------------------------|
| High | High | - | No valid data | No valid data |
| Low | Low | High | Valid data bits 8-15 | Valid data bits 0-7 |
| High | Low | High | No valid data | Valid data bits 0-7 |
| Low | High | High | Valid data bits 8-15 | No valid data |
| Low | Low | Low | Valid data bits 8-15 | Valid data bits 0-7 |
| High | Low | Low | Valid data bits 0-7* | Valid data bits 0-7 |
| Low | High | Low | Valid data bits 8-15 | Valid data bits 8-15* |

^{*}These conditions are a result of current implementation and may not appear on future devices

Data Transfer Acknowledge (DTACK). This input indicates that the data transfer is completed When the processor recognizes DTACK during a read cycle, data is latched and the bus cycle terminated When DTACK is recognized during a write cycle, the bus cycle is terminated An active transition of data transfer acknowledge, DTACK, indicates the termination of a data transfer on the bus

If the system must run at a maximum rate determined by RAM access times, the relationship between the times at which $\overline{\text{DTACK}}$ and DATA are sampled are important

All control and data lines are sampled during the MC68000's clock high time. The clock is internally buffered, which results in some slight differences in the sampling and recognition of various signals. MC68000 mask sets prior to CC1 (R9M and T6E), allowed DTACK to be recognized as early as S2 (bus state 2), and all devices allow BERR or DTACK to be recognized in S4, S6, etc., which terminates the cycle. The DTACK signal, like other control signals, is internally synchronized to allow for valid operation in an asynchronous system. If the required setup time (#47) is met during S4, DTACK will be recognized during S5 and S6, and data will be captured during S6. The data must meet the required setup time (#27).

If an asynchronous control signal does not meet the required setup time, it is possible that it may not be recognized during that cycle. Because of this, asynchronous systems must not allow $\overline{\text{DTACK}}$ to precede data by more than parameter #31

Asserting DTACK (or BERR) on the rising edge of a clock (such as S4) after the assertion of address strobe will allow a MC68000 system to run at its maximum bus rate. If setup times #27 and #47 are guaranteed, #31 may be ignored.

BUS ARBITRATION CONTROL. These three signals form a bus arbitration circuit to determine which device will be the bus master device

Bus Request (\overline{BR}). This input is wire ORed with all other devices that could be bus masters. This input indicates to the processor that some other device desires to become the bus master.

Bus Grant (\overline{BG}). This output indicates to all other potential bus master devices that the processor will release bus control at the end of the current bus cycle

Bus Grant Acknowledge (BGACK). This input indicates that some other device has become the bus master. This signal cannot be asserted until the following four conditions are met.

- I a Bus Grant has been received
- Address Strobe is inactive which indicates that the microprocessor is not using the bus
- Data Transfer Acknowledge is inactive which indicates that neither memory nor peripherals are using the bus
- 4 Bus Grant Acknowledge is inactive which indicates that no other device is still claiming bus mastership

INTERRUPT CONTROL (IPLO, IPL1, IPL2). These input pins indicate the encoded priority level of the device requesting an interrupt Level seven is the highest priority while level zero indicates that no interrupts are requested. The least significant bit is given in IPL0 and the most significant bit is contained in IPL2.

SYSTEM CONTROL. The system control inputs are used to either reset or halt the processor and to indicate to the processor that bus errors have occurred. The three system control inputs are explained in the following paragraphs.

Bus Error (BERR). This input informs the processor that there is a problem with the cycle currently being executed. Problems may be a result of.

- 1 nonresponding devices
- 2. interrupt vector number acquisition failure
- illegal access request as determined by a memory management unit
- 4 other application dependent errors

The bus error signal interacts with the halt signal to determine if exception processing should be performed or the current bus cycle should be retried.

Refer to **BUS ERROR AND HALT OPERATION** paragraph for additional information about the interaction of the bus error and halt signals.

Reset (RESET). This bidirectional signal line acts to reset (initiate a system initialization sequence) the processor in response to an external reset signal. An internally generated reset (result of a RESET instruction) causes all external devices to be reset and the internal state of the processor is not affected. A total system reset (processor and external devices) is the result of external HALT and RESET signals applied at the same time. Refer to RESET OPERATION paragraph for additional information about reset operation.

Halt (HALT). When this bidirectional line is driven by an external device, it will cause the processor to stop at the completion of the current bus cycle. When the processor has been halted using this input, all control signals are inactive and all three-state lines are put in their high-impedance state Refer to BUS ERROR AND HALT OPERATION paragraph for additional information about the interaction between the halt and bus error signals

When the processor has stopped executing instructions, such as in a double bus fault condition, the halt line is driven by the processor to indicate to external devices that the processor has stopped

M6800 PERIPHERAL CONTROL. These control signals are used to allow the interfacing of synchronous M6800 peripheral devices with the asynchronous MC68000 These signals are explained in the following paragraphs

Enable (E). This signal is the standard enable signal common to all M6800 type peripheral devices. The period for this output is ten MC68000 clock periods (six clocks low, four clocks high)

Valid Peripheral Address (VPA). This input indicates that the device or region addressed is a M6800 family device and that data transfer should be synchronized with the enable (E) signal. This input also indicates that the processor should use automatic vectoring for an interrupt. Refer to INTERFACE WITH M6800 PERIPHERALS.

Valid Memory Address (\overline{VMA}). This output is used to indicate to M6800 peripheral devices that there is a valid address on the address bus and the processor is synchronized to enable. This signal only responds to a valid peripheral address (\overline{VPA}) input which indicates that the peripheral is a M6800 family device

PROCESSOR STATUS (FC0, FC1, FC2). These function code outputs indicate the state (user or supervisor) and the cycle type currently being executed, as shown in Table 2 The information indicated by the function code outputs is valid whenever address strobe $(\overline{\rm AS})$ is active

TABLE 2 - FUNCTION CODE OUTPUTS

| FC2 | FC1 | FC0 | Cycle Type |
|------|------|------|-----------------------|
| Low | Low | Low | (Undefined, Reserved) |
| Low | Low | High | User Data |
| Low | High | Low | User Program |
| Low | High | High | (Undefined, Reserved) |
| High | Low | Low | (Undefined, Reserved) |
| High | Low | High | Supervisor Data |
| High | High | Low | Supervisor Program |
| Hıgh | High | Hıgh | Interrupt Acknowledge |

CLOCK (CLK). The clock input is a TTL-compatible signal that is internally buffered for development of the internal clocks needed by the processor. The clock input shall be a constant frequency

SIGNAL SUMMARY. Table 3 is a summary of all the signals discussed in the previous paragraphs.

Three Signal Name Mnemonic Input/Output **Active State** State A1-A23 Address Bus output high ves Data Bus D0-D15 input/output high Ves ĀS Address Strobe output low ves read-high R/W Read/Write output ves write-low Upper and Lower Data Strobes UDS, LDS output low ves Data Transfer Acknowledge DTACK low input nο BR **Bus Request** input low no RG Bus Grant output low nο **BGACK** Bus Grant Acknowledge low input IPLO, IPL1, IPL2 Interrupt Priority Level input low no Bus Error BERR low input no RESET Reset input/output low no* Halt HALT no* input/output low Enable F high output nο VMA Valid Memory Address output low ves Valid Peripheral Address VPA input low nο FC0, FC1, FC2 Function Code Output output high ves Clock CLK input high no Power Input Vcc input

TABLE 3 - SIGNAL SUMMARY

REGISTER DESCRIPTION AND DATA ORGANIZATION

GND

The following paragraphs describe the registers and data organization of the MC68000

OPERAND SIZE

Operand sizes are defined as follows: a byte equals 8 bits, a word equals 16 bits, and a long word equals 32 bits. The operand size for each instruction is either explicitly encoded in the instruction or implicitly defined by the instruction operation. All explicit instructions support byte, word or long word operands. Implicit instructions support some subset of all three sizes.

DATA ORGANIZATION IN REGISTERS

The eight data registers support data operands of 1, 8, 16, or 32 bits. The seven address registers together with the active stack pointer support address operands of 32 bits

DATA REGISTERS. Each data register is 32 bits wide. Byte operands occupy the low order 8 bits, word operands the low order 16 bits, and long word operands the entire 32 bits. The least significant bit is addressed as bit zero; the most significant bit is addressed as bit 31.

When a data register is used as either a source or destination operand, only the appropriate low-order portion is changed; the remaining high-order portion is neither used nor changed.

ADDRESS REGISTERS. Each address register and the stack pointer is 32 bits wide and holds a full 32 bit address.

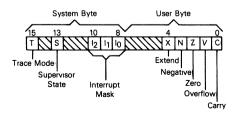
Address registers do not support byte sized operands Therefore, when an address register is used as a source operand, either the low order word or the entire long word operand is used depending upon the operation size. When an address register is used as the destination operand, the entire register is affected regardless of the operation size. If the operation size is word, any other operands are sign extended to 32 bits before the operation is performed.

STATUS REGISTER

input

The status register contains the interrupt mask (eight levels available) as well as the condition codes, extend (X), negative (N), zero (Z), overflow (V), and carry (C). Additional status bits indicate that the processor is in a trace (T) mode and/or in a supervisor (S) state.

STATUS REGISTER



Ground **≭**open drain

MC68000L4•MC68000L6•MC68000L8•MC68000L10

DATA ORGANIZATION IN MEMORY

Bytes are individually addressable with the high order byte having an even address the same as the word, as shown in Figure 9. The low order byte has an odd address that is one count higher than the word address Instructions and multibyte data are accessed only on word (even byte) boundaries. If a long word datum is located at address n (n even), then the second word of that datum is located at address n+2.

The data types supported by the MC68000 are bit data, integer data of 8, 16, or 32 bits, 32-bit addresses and binary coded decimal data. Each of these data types is put in memory, as shown in Figure 10.

BUS OPERATION

The following paragraphs explain control signal and bus operation during data transfer operations, bus arbitration, bus error and halt conditions, and reset operation

DATA TRANSFER OPERATIONS. Transfer of data between devices involves the following leads.

- Address Bus A1 through A23
- Data Bus D0 through D15
- Control Signals

The address and data buses are separate parallel buses used to transfer data using an asynchronous bus structure. In all cycles, the bus master assumes responsibility for deskewing all signals it issues at both the start and end of a cycle. In addition, the bus master is responsible for deskewing the acknowledge and data signals from the slave device.

The following paragraphs explain the read, write, and read-modify-write cycles. The indivisible read-modify-write cycle is the method used by the MC68000 for interlocked multiprocessor communications.

NOTE

The terms assertion and negation will be used extensively This is done to avoid confusion when dealing with a mixture of "active-low" and "active-lnigh" signals. The term assert or assertion is used to indicate that a signal is active or true independent of whether that voltage is low or high. The term negate or negation is used to indicate that a signal is inactive or false.

Read Cycle. During a read cycle, the processor receives data from memory or a peripheral device. The processor reads bytes of data in all cases. If the instruction specifies a word (or double word) operation, the processor reads both bytes. When the instruction specifies byte operation, the processor uses an internal A0 bit to determine which byte to read and then issues the data strobe required for that byte. For byte operations, when the A0 bit equals zero, the upper data strobe is issued. When the A0 bit equals one, the lower data strobe is issued. When the data is received, the processor correctly positions it internally.

A word read cycle flow chart is given in Figure 11. A byteread cycle flow chart is given in Figure 12. Read cycle timing is given in Figure 13. Figure 14 details word and byte read cycle operations.

FIGURE 9 - WORD ORGANIZATION IN MEMORY

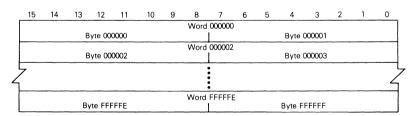


FIGURE 10 - DATA ORGANIZATION IN MEMORY

Bit Data 1 Byte = 8 Bits

| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---|---|---|---|---|---|---|---|
| | | | | | | | |
| | | | | | | | |

Integer Data 1 Byte = 8 Bits

| 15 | 14 | 13 | 12 | 11 | 10 | _ 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-----|----|----|-----|-----|----|-----|-----|---|---|---|-----|------|---|---|---|
| MSB | | | Byt | e 0 | | | LSB | | | | Ву | te 1 | | | |
| | | | Byt | e 2 | | | | | | | Byt | e 3 | | | |

1 Word = 16 Bits

| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-----|----|----|----|----|----|---|-----|------|---|---|---|---|---|---|-----|
| | | | | | | | Wo | rd 0 | | | | | | | |
| MSB | | | | | | | | | | | | | | | LSB |
| ł | | | | | | | Wo | 1 | | | | | | | |
| | | | | | | | VVO | 10 1 | | | | | | | |
| | | | | | | | Wo | rd 2 | | | | | | | |

1 Long Word = 32 Bits

| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | _ 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|------------|--------|--------|-------|----|----|---|------|-------|---|---|---|---|---|---|-----|
| MSB — - | — Long | a Word | 10 | | | _ | Hıgh | Order | | | | | | | |
| _ | | | | | | | Low | Order | | | | | | | LSB |
| | — Long | y Word | 1 | | | | | | | | | | | | |
| | — Long | y Word | 2 — - | | | _ | | | | | | | | | |

Addresses 1 Address = 32 Bits

| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-----|------|---------|-------|----|----|---|------|-------|---|---|---|---|---|---|-----|
| MSB | – Ad | dress 0 |) — - | | | | High | Order | | | | | | | |
| | | | | | | | Low | Order | | | | | | | LSB |
| | - Ad | dress 1 | | | | | | | | | | | | | |
| | – Ad | dress 2 | | | | | | | | | | | | | |

MSB = Most Significant Bit LSB = Least Significant Bit

Decimal Data
2 Binary Coded Decimal Digits = 1 Byte

| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-----|-----|------|----|----|----|-----|-----|---|-----|-----|---|---|----|-----|---|
| MSD | 200 | | | | | | | | 200 | | | | | | |
| | BCI | J () | | | ВС | וט | LSD | | BCI |) 2 | | | ВС | 03 | |
| | ВС | D 4 | | | вс | D 5 | | | ВС | 0 6 | | | ВС | D 7 | |

MSD = Most Significant Digit LSD = Least Significant Digit

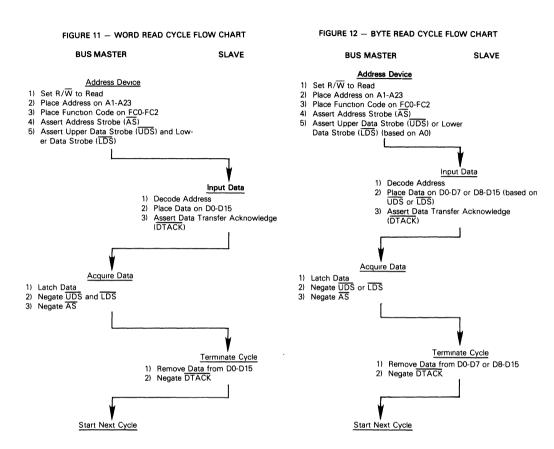


FIGURE 13 — READ AND WRITE CYCLE TIMING DIAGRAM

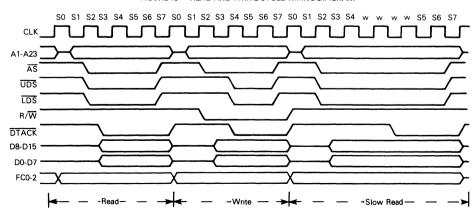
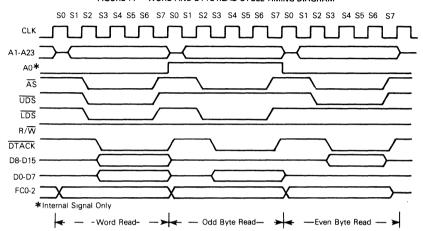


FIGURE 14 - WORD AND BYTE READ CYCLE TIMING DIAGRAM



Write Cycle. During a write cycle, the processor sends data to memory or a peripheral device. The processor writes bytes of data in all cases. If the instruction specifies a word operation, the processor writes both bytes. When the instruction specifies a byte operation, the processor uses an internal. A0 bit to determine which byte to write and then issues the data strobe required for that byte. For byte operations, when the A0 bit equals zero, the upper data strobe is issued. A word write cycle flow chart is given in Figure 15. A byte write cycle flow chart is given in Figure 16. Write cycle timing is given in Figure 13. Figure 17 details word and byte write cycle operation.

Read-Modify-Write Cycle. The read-modify-write cycle performs a read, modifies the data in the arithmetic-logic unit, and writes the data back to the same address. In the MC68000 this cycle is indivisible in that the address strobe is asserted throughout the entire cycle. The test and set (TAS) instruction uses this cycle to provide meaningful communication between processors in a multiple processor environment. This instruction is the only instruction that uses the read-modify-write cycles and since the test and set instruction only operates on bytes, all read-modify-write cycles are byte operations. A read-modify-write cycle flow chart is given in Figure 18 and a timing diagram is given in Figure 19.

BUS ARBITRATION. Bus arbitration is a technique used by master-type devices to request, be granted, and acknowledge bus mastership. In its simplest form, it consists of

- Asserting a bus mastership request
- 2 Receiving a grant that the bus is available at the end of the current cycle
- 3 Acknowledging that mastership has been assumed.

Figure 20 is a flow chart showing the detail involved in a request from a single device. Figure 21 is a timing diagram for the same operations. This technique allows processing of bus requests during data transfer cycles.

The timing diagram shows that the bus request is negated at the time that an acknowledge is asserted. This type of operation would be true for a system consisting of the processor and one device capable of bus mastership. In systems flaving a number of devices capable of bus mastership, the bus request line from each device is wire ORed to the processor. In this system, it is easy to see that there could be more than one bus request being made. The timing diagram shows that the bus grant signal is negated a few clock cycles after the transition of the acknowledge (BGACK) signal.

However, if the bus requests are still pending, the processor will assert another bus grant within a few clock cycles after it was negated. This additional assertion of bus grant allows external arbitration circuitry to select the next bus master before the current bus master has completed its requirements. The following paragraphs provide additional information about the three steps in the arbitration process

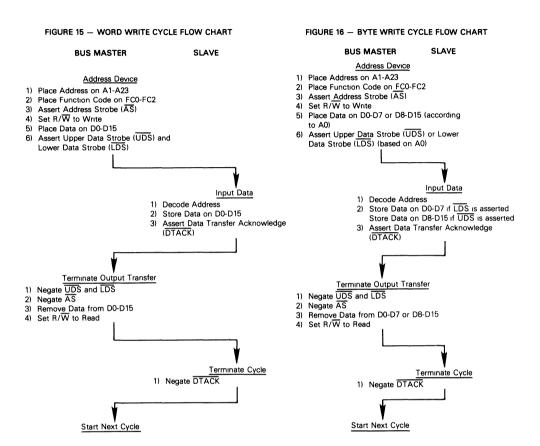
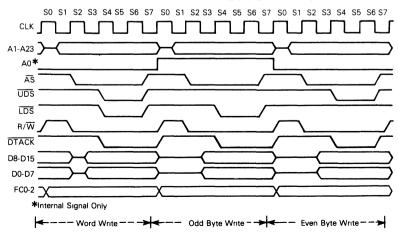
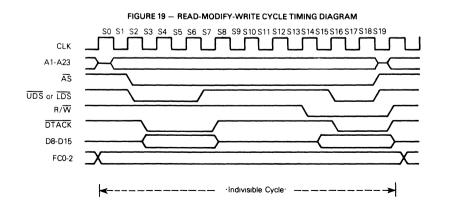


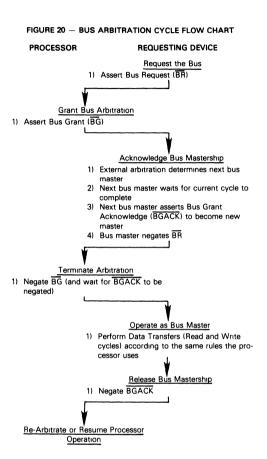
FIGURE 17 - WORD AND BYTE WRITE CYCLE TIMING DIAGRAM



Start Next Cycle

FIGURE 18 - READ-MODIFY-WRITE CYCLE FLOW CHART **BUS MASTER** SLAVE Address Device Place Address on A1-A23
 Set R/W to Read Input Data 1) Decode Address 3) Assert Address Strobe (AS) 2) Place Data on D0-D7 or D8-D15 4) Assert Upper Data Strobe (UDS) or Lower 3) Assert Data Transfer Acknowledge (DTACK) Data Strobe (LDS) Acquire Data 1) Latch Data 2) Negate UDS or LDS 3) Start Data Modification Terminate Cycle 1) Remove Data from D0-D7 or D8-D15 2) Negate DTACK Start Output Transfer 1) Set R/W to Write 2) Place Data on D0-D7 or D8-D15 Input Data 3) Assert Upper Data Strobe (UDS) or Lower 1) Store Data on D0-D7 or D8-D15 Data Strobe (LDS) Assert Data Transfer Acknowledge Terminate Output Transfer 1) Negate UDS or LDS 2) Negate AS 3) Remove Data from D0-D7 or D8-D15 4) Set R/W to Read Terminate Cycle 1) Negate DTACK





Requesting the Bus. External devices capable of becoming bus masters request the bus by asserting the bus request (BR) signal This is a wire ORed signal (although it need not be constructed from open collector devices) that indicates to the processor that some external device requires control of the external bus. The processor is effectively at a lower bus. priority level than the external device and will relinquish the bus after it has completed the last bus cycle it has started

When no acknowledge is received before the bus request signal goes inactive, the processor will continue processing when it detects that the bus request is inactive. This allows ordinary processing to continue if the arbitration circuitry responded to noise inadvertently

Receiving the Bus Grant. The processor asserts bus grant (BG) as soon as possible Normally this is immediately after internal synchronization. The only exception to this occurs when the processor has made an internal decision to execute the next bus cycle but has not progressed far enough into the cycle to have asserted the address strobe (AS) signal. In this case, bus grant will not be asserted until one clock after address strobe is asserted to indicate to external devices that a bus cycle is being executed

The bus grant signal may be routed through a daisychained network or through a specific priority-encoded network. The processor is not affected by the external method of arbitration as long as the protocol is obeyed

Acknowledgement of Mastership. Upon receiving a bus grant, the requesting device waits until address strobe, data transfer acknowledge, and bus grant acknowledge are negated before issuing its own BGACK. The negation of the address strobe indicates that the previous master has completed its cycle, the negation of bus grant acknowledge indicates that the previous master has released the bus (While address strobe is asserted no device is allowed to "break into" a cycle.) The negation of data transfer acknowledge indicates the previous slave has terminated its connection to the previous master. Note that in some applications data transfer acknowledge might not enter into this function. General purpose devices would then be connected such that

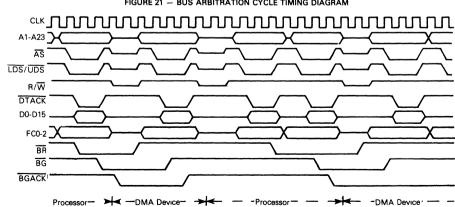


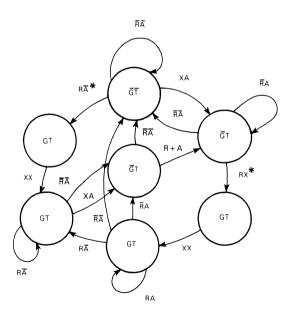
FIGURE 21 - BUS ARBITRATION CYCLE TIMING DIAGRAM

they were only dependent on address strobe. When bus grant acknowledge is issued the device is bus master until it negates bus grant acknowledge. Bus grant acknowledge sould not be negated until after the bus cycle(s) is (are) completed. Bus mastership is terminated at the negation of bus grant acknowledge.

The bus request from the granted device should be dropped after bus grant acknowledge is asserted. If a bus request is still pending, another bus grant will be asserted within a few clocks of the negation of bus grant. Refer to Bus Arbitration Control section. Note that the processor does not perform any external bus cycles before it re-asserts bus grant.

BUS ARBITRATION CONTROL. The bus arbitration control unit in the MC68000 is implemented with a finite state machine. A state diagram of this machine is shown in Figure 22. All asynchronous signals to the MC68000 are synchronized before being used internally. This synchronization is accomplished in a maximum of one cycle of the system clock, assuming that the asynchronous input setup time (#47) has

FIGURE 22 — STATE DIAGRAM OF MC68000 BUS ARBITRATION UNIT



R = Bus Request Internal

A = Bus Grant Acknowledge Internal

G = Bus Grant

T= Three-State Control to Bus Control Logic

X = Don't Care

been met (see Figure 23) The input signal is sampled on the falling edge of the clock and is valid internally after the next falling edge

As shown in Figure 22, input signals labeled R and A are internally synchronized on the bus request and bus grant acknowledge pins respectively. The bus grant output is labeled G and the internal three-state control signal T. If T is true, the address, data, and control buses are placed in a high-impedance state when $\overline{\rm AS}$ is negated. All signals are shown in positive logic (active high) regardless of their true active voltage level

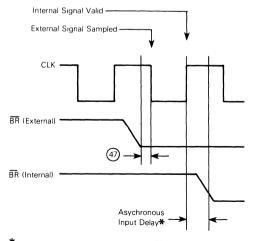
State changes (valid outputs) occur on the next rising edge after the internal signal is valid

A timing diagram of the bus arbitration sequence during a processor bus cycle is shown in Figure 24. The bus arbitration sequence while the bus is inactive (i.e., executing internal operations such as a multiply instruction) is shown in Figure 25.

If a bus request is made at a time when the MPU has already begun a bus cycle but \overline{AS} has not been asserted (bus state S0), \overline{BG} will not be asserted on the next rising edge Instead, \overline{BG} will be delayed until the second rising edge following it's internal assertion. This sequence is shown in Figure 26.

BUS ERROR AND HALT OPERATION. In a bus architecture that requires a handshake from an external device, the possibility exists that the handshake might not occur. Since different systems will require a different maximum response time, a bus error input is provided. External circuitry must be used to determine the duration between address strobe and data transfer acknowledge before issuing a bus error signal. When a bus error signal is received, the processor has two options: initiate a bus error exception sequence or try running the bus cycle again.

FIGURE 23 — TIMING RELATIONSHIP OF EXTERNAL ASYNCHRONOUS INPUTS TO INTERNAL SIGNALS



^{*}This delay time is equal to parameter #33,tcHGL

^{*} State machine will not change state if bus is in S0. Refer to BUS ARBITRATION CONTROL for additional information

FIGURE 24 - BUS ARBITRATION DURING PROCESSOR BUS CYCLE

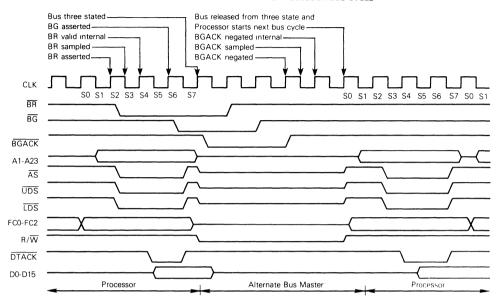
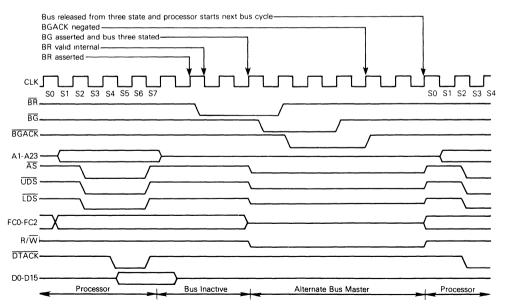


FIGURE 25 - BUS ARBITRATION WITH BUS INACTIVE



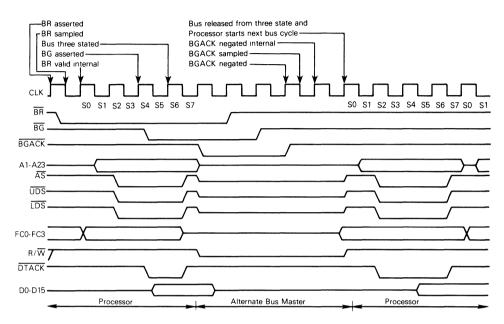


FIGURE 26 - BUS ARBITRATION DURING PROCESSOR BUS CYCLE SPECIAL CASE

Exception Sequence. When the bus error signal is asserted, the current bus cycle is terminated If $\overline{\text{BERR}}$ is asserted before the falling edge of S4, $\overline{\text{AS}}$ will be negated in S7 in either a read or write cycle. As long as $\overline{\text{BERR}}$ remains asserted, the data and address buses will be in the high-impedance state. When $\overline{\text{BERR}}$ is negated, the processor will begin stacking for exception processing. Figure 27 is a timing diagram for the exception sequence. The sequence is composed of the following elements.

- 1 Stacking the program counter and status register
- 2 Stacking the error information

- 3 Reading the bus error vector table entry
- 4 Executing the bus error handler routine

The stacking of the program counter and the status register is the same as if an interrupt had occurred. Several additional items are stacked when a bus error occurs. These items are used to determine the nature of the error and correct it, if possible. The bus error vector is vector number two located at address \$000008. The processor loads the new program counter from this location. A software bus error handler routine is then executed by the processor. Refer to EXCEPTION PROCESSING for additional information.

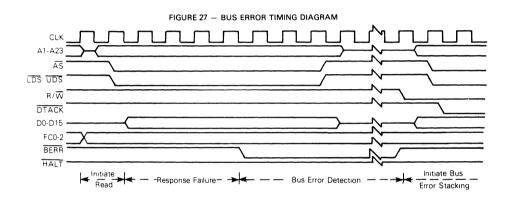
Re-Running the Bus Cycle. When, during a bus cycle, the processor receives a bus error signal and the halt pin is being driven by an external device, the processor enters the re-run sequence. Figure 28 is a timing diagram for re-running the bus cycle.

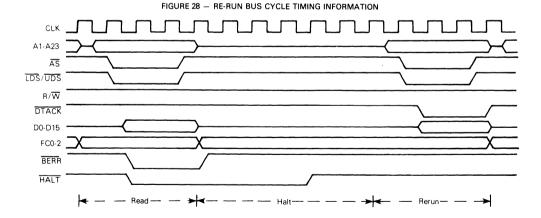
The processor terminates the bus cycle, then puts the address and data output lines in the high-impedance state. The processor remains "halted," and will not run another bus cycle until the halt signal is removed by external logic. Then the processor will re-run the previous bus cycle using

the same address, the same function codes, the same data (for a write operation), and the same controls. The bus error signal should be removed at least one clock cycle before the halt signal is removed.

NOTE

The processor will not re-run a read-modify-write cycle. This restriction is made to guarantee that the entire cycle runs correctly and that the write operation of a Test-and-Set operation is performed without ever releasing AS. If BERR and HALT are asserted during a read-modify-write bus cycle, a bus error operation results.





The processor terminates the bus cycle, then puts the address, data and function code output lines in the high-impedance state. The processor remains "halted," and will not run another bus cycle until the halt signal is removed by external logic. Then the processor will re-run the previous bus cycle using the same address, the same function codes, the same data (for a write operation), and the same controls. The bus error signal should be removed before the halt signal is removed.

Halt Operation with No Bus Error. The halt input signal to the MC68000 performs a Halt/Run/Single-Step function in a similar fashion to the M6800 halt function. The halt and run modes are somewhat self explanatory in that when the halt signal is constantly active the processor "halts" (does nothing) and when the halt signal is constantly inactive the processor "runs" (does something)

The single-step mode is derived from correctly timed transitions on the halt signal input. It forces the processor to execute a single bus cycle by entering the "run" mode until the processor starts a bus cycle then changing to the "halt" mode. Thus, the single-step mode allows the user to proceed through (and therefore debug) processor operations one bus cycle at a time.

Figure 29 details the timing required for correct single-step operations. Some care must be exercised to avoid harmful interactions between the bus error signal and the halt pin when using the single cycle mode as a debugging tool. This is also true of interactions between the halt and reset lines since these can reset the machine.

When the processor completes a bus cycle after recognizing that the halt signal is active, most three-state signals are put in the high-impedance state. These include:

- 1 address lines
- 2 data lines

This is required for correct performance of the re-run bus cycle operation

While the processor is honoring the halt request, bus arbitration performs as usual. That is, halting has no effect on bus arbitration. It is the bus arbitration function that removes the control signals from the bus.

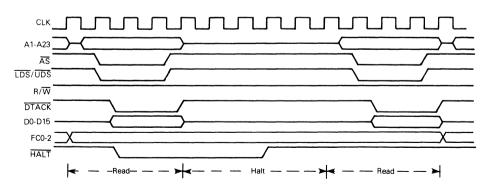
The halt function and the hardware trace capability allow the hardware debugger to trace single bus cycles or single instructions at a time. These processor capabilities, along with a software debugging package, give total debugging flexibility.

Double Bus Faults. When a bus error exception occurs, the processor will attempt to stack several words containing information about the state of the machine. If a bus error exception occurs during the stacking operation, there have been two bus errors in a row. This is commonly referred to as a double bus fault. When a double bus fault occurs, the processor will halt. Once a bus error exception has occurred, any bus error exception occurring before the execution of the next instruction constitutes a double bus fault.

Note that a bus cycle which is re-run does not constitute a bus error exception, and does not contribute to a double bus fault. Note also that this means that as long as the external hardware requests it, the processor will continue to re-run the same bus cycle.

The bus error pin also has an effect on processor operation after the processor receives an external reset input. The processor reads the vector table after a reset to determine the address to start program execution. If a bus error occurs while reading the vector table (or at any time before the first instruction is executed), the processor reacts as if a double bus fault has occurred and it halts. Only an external reset will start a halted processor.





THE RELATIONSHIP OF DTACK, BERR, AND HALT

In order to properly control termination of a bus cycle for a re-run or a bus error condition, DTACK, BERR, and HALT should be asserted and negated on the rising edge of the MC68000 clock This will assure that when two signals are asserted simultaneously, the required setup time (#47) for both of them will be met during the same bus state

This, or some equivalent precaution, should be designed external to the MC68000. Parameter #48 is intended to ensure this operation in a totally asynchronous system, and may be ignored if the above conditions are met

The preferred bus cycle terminations may be summarized as follows (case numbers refer to Table 4)

Normal Termination: DTACK occurs first (case 1)
Halt Termination: HALT is asserted at same time, or precedes DTACK (no BERR) cases 2 and 3

Bus Error Termination: BERR is asserted in lieu of, at same time, or preceding DTACK (case 4), BERR negated at same time, or after DTACK

Re-Run Termination: HALT and BERR asserted at the same time, or before DTACK (cases 6 and 7), HALT must be negated at least 1 cycle after BERR (Case 5 indicates BERR

may precede HALT on all except R9M and T6E < early mask sets > which allows fully asynchronous assertion).

Table 4 details the resulting bus cycle termination under various combinations of control signal sequences. The negation of these same control signals under several conditions is shown in Table 5 ($\overline{\text{DTACK}}$ is assumed to $\underline{\text{be negated normal-iy}}$ in all cases, for best results, both $\overline{\text{DTACK}}$ and $\overline{\text{BERR}}$ should be negated when address strobe is negated.)

Example A: A system uses a watch-dog timer to terminate accesses to un-populated address space. The timer asserts DTACK and BERR simultaneously after time-out (rase 4).

Example B: A system uses error detection on RAM contents. Designer may (a) delay DTACK until data verified, and return BERR and HALT simultaneously to re-run error cycle (case 6), or if valid, return DTACK, (b) delay DTACK until data verified, and return BERR at same time as DTACK if data in error (case 4), (c) return DTACK peor to data verification, as described in previous section. If data invalid, BERR is asserted (case 1) in next cycle. Error-handling software must know how to recover error cycle.

TABLE 4 - DTACK, BERR, HALT ASSERTION RESULTS

| Case | Control | Asserted | | |
|----------|----------|----------|-----|---|
| No. | Signal | Edge o | | Result |
| 140. | Oigi idi | N | N+2 | |
| ļ | DTACK | Α | S | Normal cycle terminate and continue |
| 1 | BERR | NA | Х | |
| L | HALT | NA | X | |
| ł | DTACK | Α | S | Normal cycle terminate and halt. Continue when HALT removed |
| 2 | BERR | NA | X | |
| | HALT | Α | S | |
| l | DTACK | NA | Α | Normal cycle terminate and halt Continue when HALT removed |
| 3 | BERR | NA | NA | |
| | HALT | Α | S | |
| | DTACK | Х | X | Terminate and take bus error trap |
| 4 | BERR | Α | S | · |
| <u> </u> | HALT | NA | NA | |
| | DTACK | NA | X | R9M, T6E, BF4: Unpredictable results, no re-run, no error trap, |
| 5 | BERR | Α | S | usually traps to vector number 0 |
| 1 | HALT | NA | Α | All others: terminate and re-run |
| | DTACK | Х | Х | Terminate and re-run |
| 6 | BERR | Α | S | |
| | HALT | Α | S | |
| | DTACK | NA | Х | Terminate and re-run when HALT removed |
| 7 | BERR | NA | Α | |
| | HALT | Α | S | |

Legend

N - the number of the current even bus state (e.g., S4, S6, etc.)

A - signal is asserted in this bus state

NA — signal is not asserted in this state

X - don't care

S - signal was asserted in previous state and remains asserted in this state

TABLE 5 - BERR AND HALT NEGATION RESULTS

| Conditions of Termination in | Control Signal | | ed on e of S | Rising state | Results — Next Cycle |
|---------------------------------|-------------------|---|-----------------|-----------------|--|
| Table A | Signal | N | | N+2 | |
| Bus Error | BERR HALT | • | or or | • | Takes bus error trap |
| Re-run | BERR HALT | • | or | | Illegal sequence, usually traps to vector number 0 |
| Re-run | BERR HALT | • | | • | Re-runs the bus cycle |
| Normal | BERR HALT | • | or | • | May lengthen next cycle |
| Normal | BERR HALT | • | or | | If next cycle is started it will be terminated as a bus error |

RESET OPERATION. The reset signal is a bidirectional signal that allows either the processor or an external signal to reset the system. Figure 30 is a timing diagram for reset operations. Both the halt and reset lines must be applied to ensure total reset of the processor.

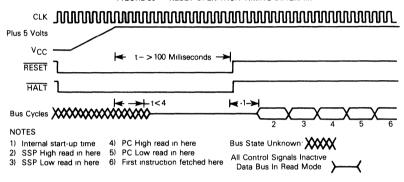
When the reset and halt lines are driven by an external device, it is recognized as an entire system reset, including the processor. The processor responds by reading the reset vector table entry (vector number zero, address \$000000) and loads it into the supervisor stack pointer (SSP). Vector table entry number one at address \$000004 is read next and loaded into the program counter. The processor initializes the status register to an interrupt level of seven. No other

registers are affected by the reset sequence.

When a RESET sequence is executed, the processor drives the reset pin for 124 clock pulses. In this case, the processor is trying to reset the rest of the system. Therefore, there is no effect on the internal state of the processor. All of the processor's internal registers and the status register are unaffected by the execution of a RESET instruction. All external devices connected to the reset line should be reset at the completion of the RESET instruction.

Asserting the Reset and Halt pins for 10 clock cycles will cause a processor reset, except when V_{CC} is initially applied to the processor. In this case, an external reset must be applied for 100 milliseconds.

FIGURE 30 - RESET OPERATION TIMING DIAGRAM



PROCESSING STATES

The MC68000 is always in one of three processing states normal, exception, or halted. The normal processing state is that associated with instruction execution, the memory of the bits in the supervisor portion of the status register are covered: the supervisor/user bit, the trace enable bit, and the processor interrupt priority mask. Finally, the sequence of memory references and actions taken by the processor on exception conditions is detailed.

The MC68000 is always in one of three processing states normal, exception, or halted. The normal processing state is that associated with instruction execution; the memory references are to fetch instructions and operands, and to store results. A special case of the normal state is the stopped state which the processor enters when a STOP instruction is executed. In this state, no further memory references are made.

The exception processing state is associated with interrupts, trap instructions, tracing and other exceptional conditions. The exception may be internally generated by an instruction or by an unusual condition arising during the execution of an instruction. Externally, exception processing can be forced by an interrupt, by a bus error, or by a reset. Exception processing is designed to provide an efficient context switch so that the processor may handle unusual conditions.

The halted processing state is an indication of catastrophic hardware failure. For example, if during the exception processing of a bus error another bus error occurs, the processor assumes that the system is unusable and halts. Only an external reset can restart a halted processor. Note that a processor in the stopped state is not in the halted state, nor vice versa.

PRIVILEGE STATES

The processor operates in one of two states of privilege the "user" state or the "supervisor" state. The privilege state determines which operations are legal, is used by the external memory management device to control and translate accesses, and is used to choose between the supervisor stack pointer and the user stack pointer in instruction references.

The privilege state is a mechanism for providing security in a computer system. Programs should access only their own code and data areas, and ought to be restricted from accessing information which they do not need and must not modify.

The privilege mechanism provides security by allowing most programs to execute in user state. In this state, the accesses are controlled, and the effects on other parts of the system are limited. The operating system executes in the supervisor state, has access to all resources, and performs the overhead tasks for the user state programs.

SUPERVISOR STATE. The supervisor state is the higher state of privilege. For instruction execution, the supervisor state is determined by the S-bit of the status register, if the S-bit is asserted (high), the processor is in the supervisor state. All instructions can be executed in the supervisor state. The bus cycles generated by instructions executed in the supervisor state are classified as supervisor references. While the processor is in the supervisor privilege state, those instructions which use either the system stack pointer implicitly or address register seven explicitly access the supervisor stack pointer.

All exception processing is done in the supervisor state, regardless of the setting of the S-bit. The bus cycles generated during exception processing are classified as supervisor references. All stacking operations during exception processing use the supervisor stack pointer.

USER STATE. The user state is the lower state of privilege. For instruction execution, the user state is determined by the S-bit of the status register, if the S-bit is negated (low), the processor is executing instructions in the user state.

Most instructions execute the same in user state as in the supervisor state. However, some instructions which have important system effects are made privileged. User programs are not permitted to execute the STOP instruction, or the RESET instruction. To ensure that a user program cannot enter the supervisor state except in a controlled manner, the instructions which modify the whole status register are privileged. To aid in debugging programs which are to be used as operating systems, the move to user stack pointer (MOVE USP) and move from user stack pointer (MOVE from USP) instructions are also privileged.

The bus cycles generated by an instruction executed in user state are classified as user state references. This allows an external memory management device to translate the address and to control access to protected portions of the address space. While the processor is in the user privilege state, those instructions which use either the system stack pointer implicitly, or address register seven explicitly, access the user stack pointer.

PRIVILEGE STATE CHANGES. Once the processor is in the user state and executing instructions, only exception processing can change the privilege state. During exception processing, the current setting of the S-bit of the status register is saved and the S-bit is asserted, putting the processing in the supervisor state. Therefore, when instruction execution resumes at the address specified to process the exception, the processor is in the supervisor privilege state.

REFERENCE CLASSIFICATION. When the processor makes a reference, it classifies the kind of reference being made, using the encoding on the three function code output lines. This allows external translation of addresses, control of access, and differentiation of special processor states, such as interrupt acknowledge. Table 6 lists the classification of references.

TABLE 6 - REFERENCE CLASSIFICATION

| Functi | on Code (| Dutput | Befores Class |
|--------|-----------|--------|-----------------------|
| FC2 | FC1 | FC0 | Reference Class |
| 0 | 0 | 0 | (Unassigned) |
| 0 | 0 | 1 | User Data |
| 0 | 1 | 0 | User Program |
| 0 | 1 | 1 | (Unassigned) |
| 1 | 0 | 0 | (Unassigned) |
| 1 | 0 | 1 | Supervisor Data |
| 1 | 1 | 0 | Supervisor Program |
| 1 | 1 | 1 | Interrupt Acknowledge |

EXCEPTION PROCESSING

Before discussing the details of interrupts, traps, and tracing, a general description of exception processing is in order. The processing of an exception occurs in four steps, with variations for different exception causes. During the first step, a temporary copy of the status register is made, and the status register is set for exception processing. In the second step the exception vector is determined, and the third step is the saving of the current processor context. In the fourth step a new context is obtained, and the processor switches to instruction processing.

EXCEPTION VECTORS. Exception vectors are memory locations from which the processor fetches the address of a routine which will handle that exception All exception vectors are two words in length (Figure 31), except for the reset vector, which is four words. All exception vectors lie in the supervisor data space, except for the reset vector which is in the supervisor program space. A vector number is an eightbit number which, when multiplied by four, gives the address of an exception vector Vector numbers are generated internally or externally, depending on the cause of the exception. In the case of interrupts, during the interrupt acknowledge bus cycle, a peripheral provides an 8-bit vector number (Figure 32) to the processor on data bus lines D0 through D7 The processor translates the vector number into a full 24-bit address, as shown in Figure 33. The memory layout for exception vectors is given in Table 7

As shown in Table 7, the memory layout is 512 words long (1024 bytes). It starts at address 0 and proceeds through address 1023. This provides 255 unique vectors, some of these are reserved for TRAPS and other system functions Of the 255, there are 192 reserved for user interrupt vectors. However, there is no protection on the first 64 entries, so user interrupt vectors may overlap at the discretion of the systems designer

KINDS OF EXCEPTIONS. Exceptions can be generated by either internal or external causes. The externally generated exceptions are the interrupts and the bus error and reset requests. The interrupts are requests from peripheral devices for processor action while the bus error and reset inputs are used for access control and processor restart. The internally generated exceptions come from instructions, or from ad-

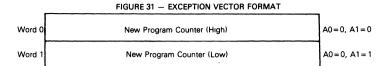


FIGURE 32 — PERIPHERAL VECTOR NUMBER FORMAT

| D15 | | D8/D7 | | | | | | | DO |
|-----|---------|-------|----|----|----|----|----|----|----|
| | Ignored | v7 | v6 | v5 | v4 | v3 | v2 | v1 | v0 |

Where

v7 is the MSB of the Vector Number v0 is the LSB of the Vector Number

FIGURE 33 - ADDRESS TRANSLATED FROM 8-BIT VECTOR NUMBER

| A23 | A10 | Α9 | A8 | Α7 | A6 | A5 | A4 | A3 | A2 | A1 | A0 |
|------------|-----|----|----|----|----|----|----|----|----|----|----|
| All Zeroes | | v7 | v6 | v5 | v4 | v3 | v2 | v1 | v0 | 0 | 0 |

TABLE 7 - EXCEPTION VECTOR ASSIGNMENT

| Vector | | Address | | Assignment | | | | |
|-----------|-------|---------|-------|--------------------------------|--|--|--|--|
| Number(s) | Dec | Hex | Space | Assignment | | | | |
| 0 | 0 | 000 | SP | Reset ⁻ Initial SSP | | | | |
| _ | 4 | 004 | SP | Reset: Initial PC | | | | |
| 2 | 8 | 008 | SD | Bus Error | | | | |
| 3 | 12 | 00C | SD | Address Error | | | | |
| 4 | 16 | 010 | SD | Illegal Instruction | | | | |
| 5 | 20 | 014 | SD | Zero Divide | | | | |
| 6 | 24 | 018 | SD | CHK Instruction | | | | |
| 7 | 28 | 01C | SD | TRAPV Instruction | | | | |
| 8 | 32 | 020 | SD | Privilege Violation | | | | |
| 9 | 36 | 024 | SD | Trace | | | | |
| 10 | 40 | 028 | SD | Line 1010 Emulator | | | | |
| 11 | 44 | 02C | SD | Line 1111 Emulator | | | | |
| 12* | 48 | 030 | SD | (Unassigned, reserved) | | | | |
| 13* | 52 | 034 | SD | (Unassigned, reserved) | | | | |
| 14* | 56 | 038 | SD | (Unassigned, reserved) | | | | |
| 15 | 60 | 03C | SD | Uninitialized Interrupt Vector | | | | |
| 16-23° | 64 | 04C | SD | (Unassigned, reserved) | | | | |
| | 95 | 05F | | _ | | | | |
| 24 | 96 | 060 | SD | Spurious Interrupt | | | | |
| 25 | 100 | 064 | SD | Level 1 Interrupt Autovector | | | | |
| 26 | · 104 | 068 | SD | Level 2 Interrupt Autovector | | | | |
| 27 | 108 | 06C | SD | Level 3 Interrupt Autovector | | | | |
| 28 | 112 | 070 | SD | Level 4 Interrupt Autovector | | | | |
| 29 | 116 | 074 | SD | Level 5 Interrupt Autovector | | | | |
| 30 | 120 | 078 | SD | Level 6 Interrupt Autovector | | | | |
| 31 | 124 | 07C | SD | Level 7 Interrupt Autovector | | | | |
| 32-47 | 128 | 080 | SD | TRAP Instruction Vectors | | | | |
| | 191 | 0BF | | _ | | | | |
| 48-63* | 192 | 0C0 | SD | (Unassigned, reserved) | | | | |
| | 255 | 0FF | | | | | | |
| 64-255 | 256 | 100 | SD | User Interrupt Vectors | | | | |
| | 1023 | 3FF | | | | | | |

^{*}Vector numbers 12, 13, 14, 16 through 23 and 48 through 63 are reserved for future enhancements by Motorola. No user peripheral devices should be assigned these numbers.

dress errors or tracing. The trap (TRAP), trap on overflow (TRAPV), check register against bounds (CHK) and divide (DIV) instructions all can generate exceptions as part of their instruction execution. In addition, illegal instructions, word fetches from odd addresses and privilege violations cause exceptions. Tracing behaves like a very high priority, internally generated interrupt after each instruction execution.

EXCEPTION PROCESSING SEQUENCE. Exception processing occurs in four identifiable steps. In the first step, an internal copy is made of the status register. After the copy is made, the S-bit is asserted, putting the processor into the supervisor privilege state. Also, the T-bit is negated which will allow the exception handler to execute unhindered by tracing. For the reset and interrupt exceptions, the interrupt priority mask is also updated.

In the second step, the vector number of the exception is determined. For interrupts, the vector number is obtained by a processor fetch, classified as an interrupt acknowledge. For all other exceptions, internal logic provides the vector number. This vector number is then used to generate the address of the exception vector.

The third step is to save the current processor status, except for the reset exception. The current program counter value and the saved copy of the status register are stacked using the supervisor stack pointer. The program counter value stacked usually points to the next unexecuted instruction, however for bus error and address error, the value stacked for the program counter is unpredictable, and may be incremented from the address of the instruction which caused the error. Additional information defining the current context is stacked for the bus error and address error exceptions.

The last step is the same for all exceptions. The new program counter value is fetched from the exception vector. The processor then resumes instruction execution. The instruction at the address given in the exception vector is fetched, and normal instruction decoding and execution is started.

MULTIPLE EXCEPTIONS. These paragraphs describe the processing which occurs when multiple exceptions arise simultaneously Exceptions can be grouped according to their occurrence and priority. The Group 0 exceptions are reset, bus error, and address error. These exceptions cause the instruction currently being executed to be aborted, and the exeception processing to commence within two clock cycles The Group 1 exceptions are trace and interrupt, as well as the privilege violations and illegal instructions. These exceptions allow the current instruction to execute to completion, but preempt the execution of the next instruction by forcing exception processing to occur (privilege violations and illegal instructions are detected when they are the next instruction to be executed) The Group 2 exceptions occur as part of the normal processing of instructions. The TRAP, TRAPV, CHK, and zero divide exceptions are in this group For these exceptions, the normal execution of an instruction may lead to exception processing

Group 0 exceptions have highest priority, while Group 2 exceptions have lowest priority. Within Group 0, reset has highest priority, followed by bus error and then address error. Within Group 1, trace has priority over external interrupts, which in turn takes priority over illegal instruction and

privilege violation Since only one instruction can be executed at a time, there is no priority relation within Group 2.

The priority relation between two exceptions determines which is taken, or taken first, if the conditions for both arise simultaneously. Therefore, if a bus error occurs during a TRAP instruction, the bus error takes precedence, and the TRAP instruction processing is aborted. In another example, if an interrupt request occurs during the execution of an instruction while the T-bit is asserted, the trace exception has priority, and is processed first. Before instruction processing resumes, however, the interrupt exception is also processed, and instruction processing commences finally in the interrupt handler routine. A summary of exception grouping and priority is given in Table 8.

TABLE 8 - EXCEPTION GROUPING AND PRIORITY

| Group | Exception | Processing |
|-------|--|---|
| 0 | Reset Bus Error Address Error | Exception processing begins within two clock cycles |
| 1 | Trace Interrupt Illegal Privilege | Exception processing begins before the next instruction |
| 2 | TRAP, TRAPV, CHK, Zero Divide | Exception processing is started by normal instruction execution |

EXCEPTION PROCESSING DETAILED DISCUSSION

Exceptions have a number of sources, and each exception has processing which is peculiar to it. The following paragraphs detail the sources of exceptions, how each arises, and how each is processed.

RESET. The reset input provides the highest exception level The processing of the reset signal is designed for system initiation, and recovery from catastrophic failure. Any processing in progress at the time of the reset is aborted and cannot be recovered. The processor is forced into the supervisor state, and the trace state is forced off. The processor interrupt priority mask is set at level seven. The vector number is internally generated to reference the reset exception vector at location 0 in the supervisor program space. Because no assumptions can be made about the validity of register contents, in particular the supervisor stack pointer, neither the program counter nor the status register is saved. The address contained in the first two words of the reset exception vector is fetched as the initial supervisor stack pointer, and the address in the last two words of the reset exception vector is fetched as the initial program counter. Finally, instruction execution is started at the address in the program counter The power-up/restart code should be pointed to by the initial program counter

The RESET instruction does not cause loading of the reset vector, but does assert the reset line to reset external devices. This allows the software to reset the system to a known state and then continue processing with the next instruction.

INTERRUPTS. Seven levels of interrupt priorities are provided. Devices may be chained externally within interrupt priority levels, allowing an unlimited number of peripheral devices to interrupt the processor. Interrupt priority levels

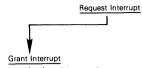
are numbered from one to seven, level seven being the highest priority. The status register contains a three-bit mask which indicates the current processor priority, and interrupts are inhibited for all priority levels less than or equal to the current processor priority

An interrupt request is made to the processor by encoding the interrupt request level on the interrupt request lines, a zero indicates no interrupt request. Interrupt requests arriving at the processor do not force immediate exception processing, but are made pending Pending interrupts are detected between instruction executions. If the priority of the pending interrupt is lower than or equal to the current processor priority, execution continues with the next instruction and the interrupt exception processing is postponed (The recognition of level seven is slightly different, as explained in a following paragraph)

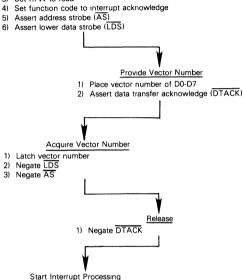
If the priority of the pending interrupt is greater than the current processor priority, the exception processing sequence is started First a copy of the status register is saved, and the privilege state is set to supervisor, tracing is suppressed, and the processor priority level is set to the level of the interrupt being acknowledged. The processor fetches the vector number from the interrupting device, classifying the reference as an interrupt acknowledge and displaying the level number of the interrupt being acknowledged on the address bus. If external logic requests an automatic vectoring, the processor internally generates a vector number which is determined by the interrupt level number. If external logic indicates a bus error, the interrupt is taken to be spurious, and the generated vector number references the spurious interrupt vector. The processor then proceeds with the usual exception processing, saving the program counter and status register on the supervisor stack. The saved value of the program counter is the address of the instruction which would have been executed had the interrupt not been present. The content of the interrupt vector whose vector number was previously obtained is fetched and loaded into the program counter, and normal instruction execution commences in the interrupt handling routine. A flow chart for the interrupt acknowledge sequence is given in Figure 34, a timing diagram is given in Figure 35, and the interrupt exception timing sequence is shown in Figure 36

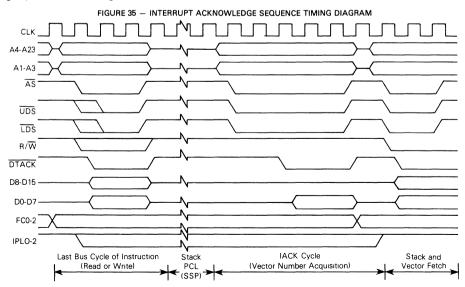
FIGURE 34 - INTERRUPT ACKNOWLEDGE SEQUENCE FLOW CHART

PROCESSOR INTERRUPTING DEVICE



- Compare interrupt level in status register and wait for current instruction to complete
- Place interrupt level on A1, A2, A3
- Set R/W to read





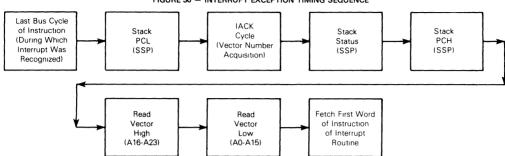


FIGURE 36 - INTERRUPT EXCEPTION TIMING SEQUENCE

Priority level seven is a special case. Level seven interrupts cannot be inhibited by the interrupt priority mask, thus providing a "non-maskable interrupt" capability. An interrupt is generated each time the interrupt request level changes from some lower level to level seven. Note that a level seven interrupt may still be caused by the level comparison if the request level is a seven and the processor priority is set to a lower level by an instruction.

UNINITIALIZED INTERRUPT. An interrupting device asserts \overline{VPA} or provides an interrupt vector during an interrupt acknowledge cycle to the MC68000 lf the vector register has not been initialized, the responding M68000 Family peripheral will provide vector 15, the unitialized interrupt vector. This provides a uniform way to recover from a programming error.

SPURIOUS INTERRUPT. If during the interrupt acknowledge cycle no device responds by asserting DTACK or VPA, the bus error line should be asserted to terminate the vector acquisition. The processor separates the processing of this error from bus error by fetching the spurious interrupt vector instead of the bus error vector. The processor then proceeds with the usual exception processing.

INSTRUCTION TRAPS. Traps are exceptions caused by instructions. They arise either from processor recognition of abnormal conditions during instruction execution, or from use of instructions' whose normal behavior is trapping.

Some instructions are used specifically to generate traps. The TRAP instruction always forces an exception, and is useful for implementing system calls for user programs. The TRAPV and CHK instructions force an exception if the user program detects a runtime error, which may be an arithmetic overflow or a subscript out of bounds.

The signed divide (DIVS) and unsigned divide (DIVU) instructions will force an exception if a division operation is attempted with a divisor of zero

ILLEGAL AND UNIMPLEMENTED INSTRUCTIONS. Illegal instruction is the term used to refer to any of the word bit patterns which are not the bit pattern of the first word of a legal instruction During instruction exception, if such an instruction is fetched, an illegal instruction exception occurs

Word patterns with bits 15 through 12 equaling 1010 or 1111 are distinguished as unimplemented instructions and separate exception vectors are given to these patterns to permit efficient emulation. This facility allows the operating system to detect program errors, or to emulate unimplemented instructions in software.

PRIVILEGE VIOLATIONS. In order to provide system security, various instructions are privileged. An attempt to execute one of the privileged instructions while in the user state will cause an exception. The privileged instructions are

STOP AND (word) Immediate to SR
RESET EOR (word) Immediate to SR
RTE OR (word) Immediate to SR

MOVE to SR MOVE USP

TRACING. To aid in program development, the MC68000 includes a facility to allow instruction by instruction tracing In the trace state, after each instruction is executed an exception is forced, allowing a debugging program to monitor the execution of the program under test

The trace facility uses the T-bit in the supervisor portion of the status register. If the T-bit is negated (off), tracing is disabled, and instruction execution proceeds from instruction to instruction as normal If the T-bit is asserted (on) at the beginning of the execution of an instruction, a trace exception will be generated after the execution of that instruction is completed. If the instruction is not executed, either because an interrupt is taken, or the instruction is illegal or privileged, the trace exception does not occur. The trace exception also does not occur if the instruction is aborted by a reset, bus error, or address error exception. If the instruction is indeed executed and an interrupt is pending on completion, the trace exception is processed before the interrupt exception If, during the execution of the instruction, an exception is forced by that instruction, the forced exception is processed before the trace exception

As an extreme illustration of the above rules, consider the arrival of an interrupt during the execution of a TRAP instruction while tracing is enabled. First the trap exception is processed, then the trace exception, and finally the interrupt exception. Instruction execution resumes in the interrupt handler routine.

BUS ERROR. Bus error exceptions occur when the external logic requests that a bus error be processed by an exception. The current bus cycle which the processor is making is then aborted. Whether the processor was doing instruction or exception processing, that processing is terminated, and the processor immediately begins exception processing.

Exception processing for bus error follows the usual sequence of steps. The status register is copied, the supervisor state is entered, and the trace state is turned off. The vector number is generated to refer to the bus error vector. Since the processor was not between instructions when the bus er-

ror exception request was made, the context of the processor is more detailed. To save more of this context, additional information is saved on the supervisor stack. The program counter and the copy of the status register are of course saved. The value saved for the program counter is advanced by some amount, two to ten bytes beyond the address of the first word of the instruction which made the reference causing the bus error. If the bus error occurred during the fetch of the next instruction, the saved program counter has a value in the vicinity of the current instruction, even if the current instruction is a branch, a jump, or a return instruction Besides the usual information, the processor saves its internal copy of the first word of the instruction being processed, and the address which was being accessed by the aborted bus cycle. Specific information about the access is also saved whether it was a read or a write, whether the processor was processing an instruction or not, and the classification displayed on the function code outputs when the bus error occurred. The processor is processing an instruction if it is in the normal state or processing a Group 2 exception, the processor is not processing an instruction if it is processing a Group 0 or a Group 1 exception. Figure 37 illustrates how this information is organized on the supervisor stack Although this information is not sufficient in general to effect full recovery from the bus error, it does allow software diagnosis Finally, the processor commences instruction processing at the address contained in the vector. It is the responsibility of the error handler routine to clean up the stack and determine where to continue execution

If a bus error occurs during the exception processing for a bus error, address error, or reset, the processor is halted, and all processing ceases. This simplifies the detection of catastrophic system failure, since the processor removes itself from the system rather than destroy all memory contents. Only the RESET pin can restart a halted processor

ADDRESS ERROR. Address error exceptions occur when the processor attempts to access a word or a long word operand or an instruction at an odd address. The effect is much like an internally generated bus error, so that the bus cycle is aborted, and the processor ceases whatever processing it is currently doing and begins exception processing. After exception processing commences, the sequence is the same as that for bus error including the information that is stacked, except that the vector number refers to the address error vector instead. Likewise, if an address error occurs dur-

ing the exception processing for a bus error, address error, or reset, the processor is halted. As shown in Figure 38, an address error will execute a short bus cycle followed by exception processing.

INTERFACE WITH M6800 PERIPHERALS

Motorola's extensive line of M6800 peripherals are directly compatible with the MC68000 Some of these devices that are particularly useful are

MC6821 Peripheral Interface Adapter

MC6840 Programmable Timer Module

MC6843 Floppy Disk Controller

MC6845 CRT Controller

MC6850 Asynchronous Communication Interface Adapter

MC6852 Synchronous Serial Data Adapter

MC6854 Advanced Data Link Controller

MC68488 General Purpose Interface Adapter

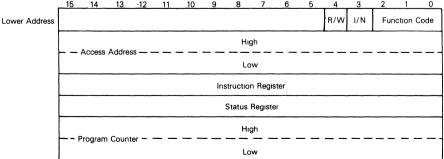
To interface the synchronous M6800 peripherals with the asynchronous MC68000, the processor modifies its bus cycle to meet the M6800 cycle requirements whenever an M6800 device address is detected. This is possible since both processors use memory mapped I/O. Figure 39 is a flow chart of the interface operation between the processor and M6800 devices.

DATA TRANSFER OPERATION

Three signals on the processor provide the M6800 interface. They are enable (E), valid memory address (\overline{VMA}), and valid peripheral address (\overline{VPA}). Enable corresponds to the E or $\phi 2$ signal in existing M6800 systems. The bus frequency is one tenth of the incoming MC68000 clock frequency. The timing of E allows 1 MHz peripherals to be used with an 8 MHz MC68000. Enable has a 60/40 duty cycle, that is, it is low for six input clocks and high for four input clocks. This duty cycle allows the processor to do successive VPA accesses on successive E pulses.

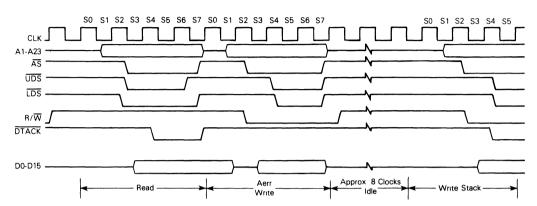
M6800 cycle timing is given in Figures 40 and 41. At state zero (S0) in the cycle, the address bus and function codes are in the high-impedance state. One-half clock later, in state 1, the address bus and function code outputs are released from the high-impedance state.

FIGURE 37 — SUPERVISOR STACK ORDER (GROUP 0) 13 ·12 11 10 9 8 7 6 5



R/W (read/write) write = 0, read = 1 I/N (instruction/not) instruction = 0, not = 1

FIGURE 38 - ADDRESS ERROR TIMING



During state 2, the address strobe (\overline{AS}) is asserted to indicate that there is a valid address on the address bus. If the bus cycle is a read cycle, the upper and/or lower data strobes are also asserted in state 2. If the bus cycle is a write cycle, the read/write (R/\overline{W}) signal is switched to low (write) during state 2. One half clock later, in state 3, the write data is placed on the data bus, and in state 4 the data strobes are issued to indicate valid data on the data bus

The processor now inserts wait states until it recognizes the assertion of \overline{VPA} . The \overline{VPA} input signals the processor that the address on the bus is the address of an M6800 device (or an area reserved for M6800 devices) and that the bus should conform to the $\phi 2$ transfer characteristics of the M6800 bus. Valid peripheral address is derived by decoding the address bus, conditioned by address strobe

After the recognition of $\overline{\text{VPA}}$, the processor assures that the Enable (E) is low, by waiting if necessary, and subsequently asserts $\overline{\text{VMA}}$ Valid memory address is then used as part of the chip select equation of the peripheral This ensures that the M6800 peripherals are selected and deselected at the correct time. The peripheral now runs its cycle during the high portion of the E signal. Figures 40 and 41 depict the best and worst case M6800 cycle timing. This cycle length is dependent strictly upon when VPA is asserted in relationship to the E clock.

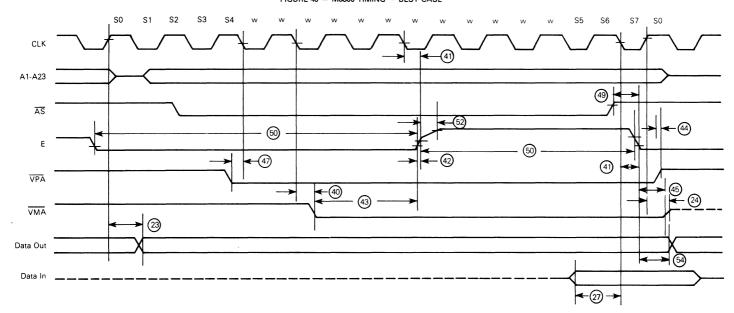
During a read cycle, the processor latches the peripheral data in state 6. For all cycles, the processor negates the address and data strobes one half clock cycle later in state 7, and the Enable signal goes low at this time. Another half clock later, the address bus is put in the high-impedance state. During a write cycle, the data bus is put in the high-impedance state and the read/write signal is switched high. The peripheral logic must remove VPA within one clock after address strobe is negated.

 $\overline{\text{DTACK}}$ should not be asserted while $\overline{\text{VPA}}$ is asserted Notice that the MC68000 $\overline{\text{VMA}}$ is active low, contrasted with the active high M6800 VMA. This allows the processor to put its buses in the high-impedance state on DMA requests without inadvertently selecting peripherals

FIGURE 39 - M6800 INTERFACING FLOW CHART **PROCESSOR** SLAVE Initiate Cycle 1) The processor starts a normal Read or Write cycle Define M6800 Cycle 1) External hardware asserts Valid Peripheral Address (VPA) Synchronize With Enable 1) The processor monitors Enable (E) until it is low (Phase 1) 2) The processor asserts Valid Memory Address (VMA) Transfer Data 1) The peripheral waits until E is active and then transfers the data Terminate Cycle 1) The processor waits until E goes low (On a Read cycle the data is latched as E goes low internally) The processor negates VMA 3) The processor negates AS, UDS, and LDS

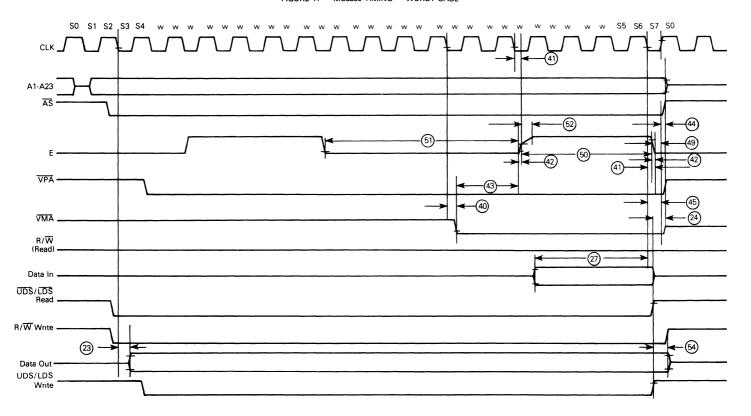
Start Next Cycle

FIGURE 40 - M6800 TIMING - BEST CASE



NOTE This figure represents the best case M6800 timing where VPA falls before the third system clock cycle after the falling edge of E

FIGURE 41 - MC6800 TIMING - WORST CASE



INTERRUPT OPERATION

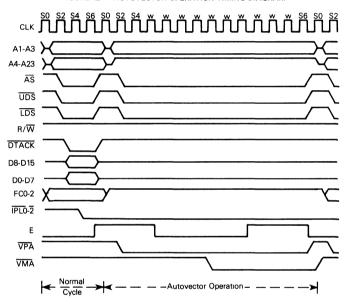
During an interrupt acknowledge cycle while the processor is fetching the vector, if VPA is asserted, the MC68000 will assert VMA and complete a normal M6800 read cycle as shown in Figure 42. The processor will then use an internally generated vector that is a function of the interrupt being serviced. This process is known as autovectoring. The seven autovectors are vector numbers 25 through 31 (decimal).

This operates in the same fashion (but is not restricted to) the M6800 interrupt sequence. The basic difference is that

there are six normal interrupt vectors and one NMI type vector. As with both the M6800 and the MC68000's normal vectored interrupt, the interrupt service routine can be located anywhere in the address space. This is due to the fact that while the vector numbers are fixed, the contents of the vector table entries are assigned by the user.

Since VMA is asserted during autovectoring, the M6800 peripheral address decoding should prevent unintended accesses.

FIGURE 42 - AUTOVECTOR OPERATION TIMING DIAGRAM



MC68000L4•MC68000L6•MC68000L8•MC68000L10

AC ELECTRICAL SPECIFICATIONS (V_{CC} = 5 0 Vdc \pm 5%, V_{SS} = 0 Vdc, T_A = 0°C to 70°C, refer to Figures 30 and 31)

| Number | Characteristic | Symbol | | 1Hz 000L4 | | /Hz 000L6 | | /Hz 1000L8 | | /Hz 000L10 | Unit |
|--------|---------------------------------------|-----------------|------|--------------|-----|--------------|------|---------------|------|---------------|------|
| | | | Min | Max | Min | Max | Min | Max | Min | Max | |
| 24 | Clock High to R/W, VMA High Impedance | tCHRZ | _ | 120 | - | 100 | - | 80 | _ | 70 | ns |
| 40 | Clock Low to VMA Low | tCLVML | _ | 90 | - | 80 | _ | 70 | _ | 70 | ns |
| 41 | Clock Low to E Transition | tCLC | - | 100 | - | 85 | - | 70 | _ | 55 | ns |
| 42 | E Output Rise and Fall Time | tErf | - | 25 | - | 25 | _ | 25 | - | 25 | ns |
| 43 | VMA Low to E High | tVMLEH | 325 | _ | 240 | _ | 200 | _ | 150 | - | ns |
| 44 | AS, DS High to VPA High | tSHVPH | 0 | 240 | 0 | 160 | 0 | 120 | 0 | 90 | ns |
| 45 | E Low to Address/VMA/FC Invalid | tELAI | 55 | - | 35 | - | 30 | _ | 10 | _ | ns |
| 49 | E Low to AS, DS Invalid | tELSI | - 80 | - | -80 | - | - 80 | _ | - 80 | _ | ns |
| 50 | E Width High | t _{EH} | 900 | _ | 600 | _ | 450 | _ | 350 | _ | ns |
| 51 | E Width Low | tEL | 1400 | _ | 900 | - | 700 | _ | 550 | _ | ns |
| 52 | E Extended Rise Time | †CIEHX | 80 | _ | 80 | - | 80 | _ | 80 | _ | ns |
| 54 | Data Hold from E Low (Write) | tELDOZ | 60 | _ | 40 | _ | 30 | _ | 20 | _ | ns |
| 23 | Clock Low to Data Out Valid | tCLDO | - | 90 | - | 80 | _ | 70 | - | 55 | ns |
| 27 | Data In to Clock Low (Setup Time) | †DICL. | 30 | - | 25 | _ | 15 | _ | 15 | - | ns |
| 47 | Asynchronous Input Setup Time | tAS1 | 30 | _ | 25 | _ | 20 | _ | 20 | | ns |

DATA TYPES AND ADDRESSING MODES

Five basic data types are supported. These data types are.

- Bits
- BCD Digits (4-bits)
- Bytes (8-bits)
- Word (16-bits)
- Long Words (32-bits)

In addition, operations on other data types such as memory addresses, status word data, etc , are provided for in the instruction set $\,$

The 14 addressing modes, shown in Table 9, include six basic types

- Register Direct
- Register Indirect
- Absolute
- Immediate
- Program Counter Relative
- Implied

Included in the register indirect addressing modes is the capability to do postincrementing, predecrementing, offseting and indexing. Program counter relative mode can also be modified via indexing and offsetting

TABLE 9 - ADDRESSING MODES

| Mode | Generation |
|---------------------------------------|-----------------------------------|
| Register Direct Addressing | |
| Data Register Direct | EA = Dn |
| Address Register Direct | EA = An |
| Absolute Data Addressing | |
| Absolute Short | EA = (Next Word) |
| Absolute Long | EA = (Next Two Words) |
| Program Counter Relative Addressing | |
| Relative with Offset | $EA = (PC) + d_{16}$ |
| Relative with Index and Offset | $EA = (PC) + (Xn) + d_8$ |
| Register Indirect Addressing | |
| Register Indirect | EA = (An) |
| Postincrement Register Indirect | $EA = (An), An \leftarrow An + N$ |
| Predecrement Register Indirect | $An \leftarrow An - N, EA = (An)$ |
| Register Indirect with Offset | $EA = (An) + d_{16}$ |
| Indexed Register Indirect with Offset | EA = (An) + (Xn) + dg |
| Immediate Data Addressing | |
| Immediate | DATA = Next Word(s) |
| Quick Immediate | Inherent Data |
| Implied Addressing | |
| Implied Register | EA = SR, USP, SP, PC |

NOTES:

EA = Effective Address

An = Address Register

Dn = Data Register

Xn = Address or Data Register used as Index Register

SR = Status Register
PC = Program Counter

() = Contents of

d₈ = Eight-bit Offset (displacement) d₁₆ = Sixteen-bit Offset (displacement) N = 1 for Byte, 2 for

Words and 4 for Long Words

← = Replaces

INSTRUCTION SET OVERVIEW

The MC68000 instruction set is shown in Table 10. Some additional instructions are variations, or subsets, of these and they appear in Table 11. Special emphasis has been given to the instruction set's support of structured high-level languages to facilitate ease of programming. Each instruction, with few exceptions, operates on bytes, words, and

long words and most instructions can use any of the 14 addressing modes. Combining instruction types, data types, and addressing modes, over 1000 useful instructions are provided. These instructions include signed and unsigned multiply and divide, "quick" arithmetic operations, BCD arithmetic and expanded operations (through traps).

TABLE 10 - INSTRUCTION SET

| Mnemonic | Description | Mnemonic | Description | Mnemonic | Description |
|----------|-------------------------------|----------|----------------------------|----------|------------------------------|
| ABCD | Add Decimal with Extend | EOR | Exclusive Or | PEA | Push Effective Address |
| ADD | Add | EXG | Exchange Registers | RESET | Reset External Devices |
| AND | Logical And | EXT | Sign Extend | ROL | Rotate Left without Extend |
| ASL | Arithmetic Shift Left | JMP | Jump | ROR | Rotate Right without Extend |
| ASR | Arithmetic Shift Right | JSR | Jump to Subroutine | ROXL | Rotate Left with Extend |
| BCC | Branch Conditionally | LEA | Load Effective Address | ROXR | Rotate Right with Extend |
| BCHG | Bit Test and Change | LINK | Link Stack | RTE | Return from Exception |
| BCLR | Bit Test and Clear | LSL | Logical Shift Left | RTR | Return and Restore |
| BRA | Branch Always | LSR | Logical Shift Right | RTS | Return from Subroutine |
| BSET | Bit Test and Set | MOVE | Move | SBCD | Subtract Decimal with Extend |
| BSR | Branch to Subroutine | MOVEM | Move Multiple Registers | scc | Set Conditional |
| BTST | Bit Test | MOVEP | Move Peripheral Data | STOP | Stop |
| СНК | Check Register Against Bounds | MULS | Signed Multiply | SUB | Subtract |
| CLR | Clear Operand | MULU | Unsigned Multiply | SWAP | Swap Data Register Halves |
| CMP | Compare | NBCD | Negate Decimal with Extend | TAS | Test and Set Operand |
| DBCC | Test Condition, Decrement and | NEG | Negate | TRAP | Trap |
| | Branch | NOP | No Operation | TRAPV | Trap on Overflow |
| DIVS | Signed Divide | NOT | One's Complement | TST | Test |
| DIVU | Unsigned Divide | OR | Logical Or | UNLK | Unlink |

TABLE 11 - VARIATIONS OF INSTRUCTION TYPES

| Instruction Type | Variation | Description | Instruction Type | Variation | Description |
|---------------------|-------------------------------------|---|---------------------|--|--|
| ADD | ADD ADDA ADDQ ADDI ADDX | Add Add Address Add Quick Add Immediate Add with Extend | MOVE | MOVE MOVEA MOVEQ MOVE from SR MOVE to SR | Move Move Address Move Quick Move from Status Register Move to Status Register |
| AND | AND ANDI | Logical And And Immediate | | MOVE to CCR MOVE USP | Move to Condition Codes Move User Stack Pointer |
| СМР | CMP CMPA | Compare Compare Address | NEG | NEGX | Negate Negate with Extend |
| | CMPM CMPI | Compare Memory Compare Immediate | OR | OR ORI | Logical Or Or Immediate |
| EOR | EOR EORI | Exclusive Or Exclusive Or Immediate | SUB | SUB SUBA SUBI SUBQ SUBX | Subtract Subtract Address Subtract Immediate Subtract Quick Subtract with Extend |

MC68000L4•MC68000L6•MC68000L8•MC68000L10

The following paragraphs contain an overview of the form and structure of the MC68000 instruction set. The instructions form a set of tools that include all the machine functions to perform the following operations.

Data Movement

Integer Arithmetic

Logical

Shift and Rotate

Bit Manipulation

Binary Coded Decimal

Program Control

System Control

The complete range of instruction capabilities combined with the flexible addressing modes described previously provide a very flexible base for program development

ADDRESSING

Instructions for the MC68000 contain two kinds of information the type of function to be performed, and the location of the operand(s) on which to perform that function The methods used to locate (address) the operand(s) are explained in the following paragraphs

Instructions specify an operand location in one of three ways

Register Specification — the number of the register is given in the register field of the instruction

Effective Address — use of the different effective address modes

Implicit Reference — the definition of certain instructions implies the use of specific registers

DATA MOVEMENT OPERATIONS

The basic method of data acquisition (transfer and storage) is provided by the move (MOVE) instruction. The move instruction and the effective addressing modes allow both address and data manipulation Data move instructions allow byte, word, and long word operands to be transferred from memory to memory, memory to register, register to memory, and register to register. Address move instructions allow word and long word operand transfers and ensure that only legal address manipulations are executed. In addition to the general move instruction there are several special data movement instructions move multiple registers (MOVEM), move peripheral data (MOVEP), exchange registers (EXG), load effective address (LEA), push effective address (PEA), link stack (LINK), unlink stack (UNLK), and move quick (MOVEQ) Table 12 is a summary of the data movement operations

INTEGER ARITHMETIC OPERATIONS

The arithmetic operations include the four basic operations of add (ADD), subtract (SUB), multiply (MUL), and divide (DIV) as well as arithmetic compare (CMP), clear (CLR), and negate (NEG) The add and subtract instructions are available for both address and data operations, with data operations accepting all operand sizes. Address operations are limited to legal address size operands (16 or 32 bits). Data, address, and memory compare operations are also available. The clear and negate instructions may be used on all sizes of data operands.

The multiply and divide operations are available for signed and unsigned operands using word multiply to produce a long word product, and a long word dividend with word divisor to produce a word guotient with a word remainder

Multiprecision and mixed size arithmetic can be accomplished using a set of extended instructions. These instructions are add extended (ADDX), subtract extended (SUBX), sign extend (EXT), and negate binary with extend (NEGX)

A test operand (TST) instruction that will set the condition codes as a result of a compare of the operand with zero is also available. Test and set (TAS) is a synchronization instruction useful in multiprocessor systems. Table 13 is a summary of the integer arithmetic operations.

TABLE 12 - DATA MOVEMENT OPERATIONS

| Instruction | Operand Size | Operation |
|-------------|--------------|--------------------------------------|
| EXG | 32 | Rx ↔ Ry |
| LEA | 32 | EA → An |
| LINK | - | An → SP@ - SP → An SP + d → SP |
| MOVE | 8, 16, 32 | (EA)s → EAd |
| MOVEM | 16, 32 | (EA) → An, Dn An, Dn → EA |
| MOVEP | 16, 32 | (EA) → Dn Dn → EA |
| MOVEQ | 8 | #xxx → Dn |
| PEA | 32 | EA → SP@ - |
| SWAP | 32 | Dn[31 16] ↔ Dn[15 0] |
| UNLK | _ | An→Sp SP@+→An |

NOTES

s = source

d = destination a + = indirect

@ - = indirect with predecrement @ + = indirect with postdecrement

[] = bit numbers INSTRUCTION FORMAT

Instructions are from one to five words in length, as shown in Figure 43. The length of the instruction and the operation to be performed is specified by the first word of the instruction which is called the operation word. The remaining words further specify the operands. These words are either immediate operands or extensions to the effective address mode specified in the operation word.

PROGRAM/DATA REFERENCES

The MC68000 separates memory references into two classes: program references, and data references. Program references, as the name implies, are references to that section of memory that contains the program being executed. Data references refer to that section of memory that contains data. Generally, operand reads are from the data space. All operand writes are to the data space.

REGISTER SPECIFICATION

The register field within an instruction specifies the register to be used. Other fields within the instruction specify whether the register selected is an address or data register and how the register is to be used.

TABLE 13 - INTEGER ARITHMETIC OPERATIONS

| Instruction | Operand Size | Operation |
|-------------|---------------------|---|
| ADD | 8, 16, 32 | Dn + (EA) → Dn (EA) + Dn → EA (EA) + #xxx → EA |
| | 16, 32 | An + (EA) → An |
| ADDX | 8, 16, 32 16, 32 | Dx + Dy + X → Dx Ax@ - Ay@ - + X → Ax@ |
| CLR | 8, 16, 32 | 0 → EA |
| СМР | 8, 16, 32 16, 32 | Dn – (EA) (EA) – #xxx Ax@ + – Ay@ + An – (EA) |
| DIVS | 32 + 16 | Dn/(EA) → Dn |
| DIVU | 32 + 16 | Dn/(EA) → Dn |
| EXT | 8→16 16→32 | (Dn) ₈ → Dn ₁₆ (Dn) ₁₆ → Dn ₃₂ |
| MULS | 16*16→32 | Dn*(EA) → Dn |
| MULU | 16*16 → 32 | Dn*(EA) → Dn |
| NEG | 8, 16, 32 | 0 – (EA) → EA |
| NEGX | 8, 16, 32 | 0 – (EA) – X – EA |
| SUB | 8, 16, 32 16, 32 | Dn – (EA) → Dn (EA) – Dn → EA (EA) – #xxx → EA An – (EA) → An |
| SUBX | 8, 16, 32 | $Dx - Dy - X \longrightarrow Dx$ $Ax@ Ay@ X \longrightarrow Ax@$ |
| TAS | 8 | (EA) – 0, 1 → EA[7] |
| TST | 8, 16, 32 | (EA) – 0 |

NOTE. [] = bit number

EFFECTIVE ADDRESS

Most instructions specify the location of an operand by using the effective address field in the operation word. For example, Figure 44 shows the general format of the single effective address instruction operation word. The effective address is composed of two 3-bit fields, the mode field, and the register field. The value in the mode field selects the different address modes. The register field contains the number of a register.

The effective address field may require additional information to fully specify the operand. This additional information, called the effective address extension, is contained in the following word or words and is considered part of the instruction, as shown in Figure 43. The effective address modes are grouped into three categories register direct, memory addressing, and special

REGISTER DIRECT MODES. These effective addressing modes specify that the operand is in one of the 16 multifunction registers

Data Register Direct. The operand is in the data register specified by the effective address register field

Address Register Direct. The operand is in the address register specified by the effective address register field

MEMORY ADDRESS MODES. These effective addressing modes specify that the operand is in memory and provide the specific address of the operand

Address Register Indirect. The address of the operand is in the address register specified by the register field. The reference is classified as a data reference with the exception of the jump and jump to subroutine instructions.

FIGURE 43 - INSTRUCTION FORMAT

| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|----|--|----|----|----|------|--------|----------|---------|--------|------|---|---|---|---|---|
| | Operation Word | | | | | | | | | | | | | | |
| | (First Word Specifies Operation and Modes) | | | | | | | | | | | | | | |
| | Immediate Operand | | | | | | | | | | | | | | |
| | | | | | (1: | f Any, | One or | r Two ۱ | Words) | | | | | | |
| | | | | | Sour | ce Eff | ective A | Address | Exten | sion | | | | | |
| | (If Any, One or Two Words) | | | | | | | | | | | | | | |
| | Destination Effective Address Extension | | | | | | | | | | | | | | |
| 1 | (If Any, One or Two Words) | | | | | | | | | | | | | | |

FIGURE 44 — SINGLE-EFFECTIVE-ADDRESS INSTRUCTION OPERATION WORD GENERAL FORMAT

| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 3 | 2 | 1 | 0 |
|----|----|----|----|----|----|---|---|---|---|---|-------------------|------|-----------------|---|
| Х | х | Х | Х | х | х | х | Х | х | × | , | Effective Mode | Addr | ess Register | 1 |

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Address Register Indirect With Postincrement. The address of the operand is in the address register specified by the register field. After the operand address is used, it is incremented by one, two, or four depending upon whether the size of the operand is byte, word, or long word. If the address register is the stack pointer and the operand size is byte, the address is incremented by two rather than one to keep the stack pointer on a word boundary. The reference is classified as a data reference.

Address Register Indirect With Predecrement. The address of the operand is in the address register specified by the register field Before the operand address is used, it is decremented by one, two, or four depending upon whether the operand size is byte, word, or long word. If the address register is the stack pointer and the operand size is byte, the address is decremented by two rather than one to keep the stack pointer on a word boundary. The reference is classified as a data reference.

Address Register Indirect With Displacement. This address mode requires one word of extension. The address of the operand is the sum of the address in the address register and the sign-extended 16-bit displacement integer in the extension word. The reference is classified as a data reference with the exception of the jump to subroutine instructions.

Address Register Indirect With Index. This address mode requires one word of extension. The address of the operand is the sum of the address in the address register, the sign-extended displacement integer in the low order eight bits of the extension word, and the contents of the index register. The reference is classified as a data reference with the exception of the jump and jump to subroutine instructions.

SPECIAL ADDRESS MODE. The special address modes use the effective address register field to specify the special addressing mode instead of a register number

Absolute Short Address. This address mode requires one word of extension. The address of the operand is the extension word. The 16-bit address is sign extended before it is used. The reference is classified as a data reference with the exception of the jump and jump to subroutine instructions.

Absolute Long Address. This address mode requires two words of extension. The address of the operand is developed by the concatenation of the extension words. The high-order part of the address is the first extension word, the low-order part of the address is the second extension word. The reference is classified as a data reference with the exception of the jump and jump to subroutine instructions.

Program Counter With Displacement. This address mode requires one word of extension. The address of the operand is the sum of the address in the program counter and the sign-extended 16-bit displacement integer in the extension word. The value in the program counter is the address of the

extension word. The reference is classified as a program reference.

Program Counter With Index. This address mode requires one word of extension. This address is the sum of the address in the program counter, the sign-extended displacement integer in the lower eight bits of the extension word, and the contents of the index register. The value in the program counter is the address of the extension word. This reference is classified as a program reference.

Immediate Data. This address mode requires either one or two words of extension depending on the size of the operation

Byte operation — operand is low order byte of extension word

Word operation - operand is extension word

Long word operation — operand is in the two extension words, high-order 16 bits are in the first extension word, low-order 16 bits are in the second extension word.

Condition Codes or Status Register. A selected set of instructions may reference the status register by means of the effective address field. These are

> ANDI to CCR ANDI to SR EORI to CCR EORI to SR ORI to CCR ORI to SR

EFFECTIVE ADDRESS ENCODING SUMMARY

Table 14 is a summary of the effective addressing modes discussed in the previous paragraphs

TABLE 14 - EFFECTIVE ADDRESS ENCODING SUMMARY

| Addressing Mode | Mode | Register |
|---|------|-----------------|
| Data Register Direct | 000 | register number |
| Address Register Direct | 001 | register number |
| Address Register Indirect | 010 | register number |
| Address Register Indirect with Postincrement | 011 | register number |
| Address Register Indirect with Predecrement | 100 | register number |
| Address Register Indirect with Displacement | 101 | register number |
| Address Register Indirect with Index | 110 | register number |
| Absolute Short | 111 | 000 |
| Absolute Long | 111 | 001 |
| Program Counter with Displacement | 111 | 010 |
| Program Counter with Index | 111 | 011 |
| Immediate | 111 | 100 |

IMPLICIT REFERENCE

Some instructions make implicit reference to the program counter (PC), the system stack pointer (SP), the supervisor stack pointer (SSP), the user stack pointer (USP), or the status register (SR)

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SYSTEM STACK. The system stack is used implicitly by many instructions, user stacks and queues may be created and maintained through the addressing modes. Address register seven (A7) is the system stack pointer (SP). The system stack pointer is either the supervisor stack pointer (SSP) or the user stack pointer (USP), depending on the state of the S-bit in the status register. If the S-bit indicates supervisor state, SSP is the active system stack pointer, and the USP cannot be referenced as an address register. If the S-bit indicates user state, the USP is the active system stack pointer, and the SSP cannot be referenced. Each system stack fills from high memory to low memory.

LOGICAL OPERATIONS

Logical operation instructions AND, OR, EOR, and NOT are available for all sizes of integer data operands. A similar set of immediate instructions (ANDI, ORI, and EORI) provide these logical operations with all sizes of immediate data Table 15 is a summary of the logical operations

TABLE 15 - LOGICAL OPERATIONS

| Instruction | Operand Size | Operation |
|-------------|--------------|--|
| AND | 8, 16, 32 | DnΛ(EA) → Dn (EA)ΛDn → EA (EA)Λ#xxx → EA |
| OR | 8, 16, 32 | Dn v (EA) → Dn (EA) v Dn → EA (EA) v #xxx → EA |
| EOR | 8, 16, 32 | (EA) ⊕ Dy → EA (EA) ⊕ #xxx → EA |
| NOT | 8, 16, 32 | ~ (EA) → EA |

NOTE ~ = invert

SHIFT AND ROTATE OPERATIONS

Shift operations in both directions are provided by the arithmetic instructions ASR and ASL and logical shift instructions LSR and LSL. The rotate instructions (with and without extend) available are ROXR, ROXL, ROR, and ROL. All shift and rotate operations can be performed in either registers or memory. Register shifts and rotates support all operand sizes and allow a shift count specified in the instruction of one to eight bits, or 0 to 63 specified in a data register.

Memory shifts and rotates are for word operands only and allow only single-bit shifts or rotates

Table 16 is a summary of the shift and rotate operations

TABLE 16 - SHIFT AND ROTATE OPERATIONS

| Instruc- tion | Operand Size | Operation |
|------------------|-----------------|----------------|
| ASL | 8, 16, 32 | X/C ← ← 0 |
| ASR | 8, 16, 32 | → x/c |
| LSL | 8, 16, 32 | X/C ← 0 |
| LSR | 8, 16, 32 | 0 → X/C |
| ROL | 8, 16, 32 | C |
| ROR | 8, 16, 32 | > C |
| ROXL | 8, 16, 32 | C + X + X + |
| ROXR | 8, 16, 32 | x > c |

BIT MANIPULATION OPERATIONS

Bit manipulation operations are accomplished using the following instructions bit test (BTST), bit test and set (BSET), bit test and clear (BCLR), and bit test and change (BCHG). Table 17 is a summary of the bit manipulation operations. (Bit 2 of the status register is Z.)

TABLE 17 — BIT MANIPULATION OPERATIONS

| Instruction | Operand Size | Operation |
|-------------|--------------|--|
| BTST | 8, 32 | ~bit of (EA) → Z |
| BSET | 8, 32 | ~bit of (EA) → Z 1 → bit of EA |
| BCLR | 8, 32 | ~ bit of (EA) → Z 0 → bit of EA |
| BCHG | 8, 32 | ~ bit of (EA) → Z ~ bit of (EA) → bit of EA |

BINARY CODED DECIMAL OPERATIONS

Multiprecision arithmetic operations on binary coded decimal numbers are accomplished using the following instructions add decimal with extend (ABCD), subtract decimal with extend (SBCD), and negate decimal with extend (NBCD). Table 18 is a summary of the binary coded decimal operations.

TABLE 18 — BINARY CODED DECIMAL OPERATIONS

| TABLE TO BINARY CODED DECIMAL OF ENATIONS | | | | | | | | |
|---|-----------------|---|--|--|--|--|--|--|
| Instruction | Operand Size | Operation | | | | | | |
| ABCD | 8 | $Dx_{10} + Dy_{10} + X \rightarrow Dx$ $Ax@ - 10 + Ay@ - 10 + X \rightarrow Ax@$ | | | | | | |
| SBCD | 8 | $Dx_{10} - Dy_{10} - X \rightarrow Dx$ $Ax@ - 10 - Ay@ - 10 - X \rightarrow Ax@$ | | | | | | |
| NBCD | 8 | 0 – (EA) ₁₀ – X → EA | | | | | | |

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PROGRAM CONTROL OPERATIONS

Program control operations are accomplished using a series of conditional and unconditional branch instructions and return instructions. These instructions are summarized in Table 19.

The conditional instructions provide setting and branching for the following conditions

| CC | - carry clear | LS | - low or same |
|----|--------------------------------------|----|---------------------------------|
| CS | carry set | LT | less than |
| EQ | equal | MI | - minus |
| F | never true | NE | not equal |
| GE | greater or equal | PL | - plus |
| GT | greater than | Т | always true |
| HI | – high | VC | - no overflow |
| LE | less or equal | VS | overflow |

TABLE 19 - PROGRAM CONTROL OPERATIONS

| Instruction | Operation |
|---------------|---|
| Conditional | |
| BCC | Branch conditionally (14 conditions) 8- and 16-bit displacement |
| DBCC | Test condition, decrement, and branch 16-bit displacement |
| scc | Set byte conditionally (16 conditions) |
| Unconditional | |
| BRA | Branch always 8- and 16-bit displacement |
| BSR | Branch to subroutine 8- and 16-bit displacement |
| JMP | Jump |
| JSR | Jump to subroutine |
| Returns | |
| RTR | Return and restore condition codes |
| RTS | Return from subroutine |

SYSTEM CONTROL OPERATIONS

System control operations are accomplished by using privileged instructions, trap generating instructions, and instructions that use or modify the status register. These instructions are summarized in Table 20.

TABLE 20 - SYSTEM CONTROL OPERATIONS

| Instruction | Operation |
|-----------------|--------------------------------|
| Privileged | |
| RESET | Reset external devices |
| RTE | Return from exception |
| STOP | Stop program execution |
| ORI to SR | Logical OR to status register |
| MOVE USP | Move user stack pointer |
| ANDI to SR | Logical AND to status register |
| EORI to SR | Logical EOR to status register |
| MOVE EA to SR | Load new status register |
| Trap Generating | |
| TRAP | Trap |
| TRAPV | Trap on overflow |
| СНК | Check register against bounds |
| Status Register | |
| ANDI to CCR | Logical AND to condition codes |
| EORI to CCR | Logical EOR to condition codes |
| MOVE EA to CCR | Load new condition codes |
| ORI to CCR | Logical OR to condition codes |
| MOVE SR to EA | Store status register |

INSTRUCTION SET

The following paragraphs provide information about the addressing categories and instruction set of the MC68000.

ADDRESSING CATEGORIES

Effective address modes may be categorized by the ways in which they may be used. The following classifications will be used in the instruction definitions.

| Data | If an | effective address mode may be |
|------|-------|----------------------------------|
| | used | to refer to data operands, it is |

considered a data addressing effective

address mode.

Memory If an effective address mode may be used to refer to memory operands, it is

considered a memory addressing effective address mode

Alterable If an effective address mode may be

used to refer to alterable (writeable) operands, it is considered an alterable

addressing effective address mode

Control If an effective address mode may be used to refer to memory operands

without an associated size, it is considered a control addressing effective

address mode

Table 21 shows the various categories to which each of the effective address modes belong Table 22 is the instruction set summary

The status register addressing mode is not permitted unless it is explicitly mentioned as a legal addressing mode

These categories may be combined, so that additional, more restrictive, classifications may be defined. For example, the instruction descriptions use such classifications as alterable memory or data alterable. The former refers to those addressing modes which are both alterable and memory addresses, and the latter refers to addressing modes which are both data and alterable.

INSTRUCTION PRE-FETCH

The MC68000 uses a 2-word tightly-coupled instruction prefetch mechanism to enhance performance. This mechanism is described in terms of the microcode operations involved. If the execution of an instruction is defined to begin when the microroutine for that instruction is entered, some features of the prefetch mechanism can be described.

- When execution of an instruction begins, the operation word and the word following have already been fetch ed. The operation word is in the instruction decoder.
- 2) In the case of multi-word instructions, as each additional word of the instruction is used internally, a fetch is made to the instruction stream to replace it
- 3) The last fetch from the instruction stream is made when the operation word is discarded and decoding is started on the next instruction
- 4) If the instruction is a single-word instruction causing a branch, the second word is not used. But because this word is fetched by the preceding instruction, it is impossible to avoid this superfluous fetch. In the case of an interrupt or trace exception, both words are not used.
- 5) The program counter usually points to the last word fetched from the instruction stream

| TABLE 21 — | EFFECTIVE | ADDRESSING | MODE | CATEGORIES |
|------------|-----------|------------|------|------------|

| Effective Address | | | | Addressing Categories | | | |
|----------------------|------|-----------------|------|-----------------------|---------|-----------|--|
| Modes | Mode | Register | Data | Memory | Control | Alterable | |
| Dn | 000 | register number | X | - | - | X | |
| An | 001 | register number | - | - | - | X | |
| An@ | 010 | register number | X | Х | X | Х | |
| An@+ | 011 | register number | Х | X | - | X | |
| An@ | 100 | register number | Х | Х | - | X | |
| An@(d) | 101 | register number | Х | × | × | Х | |
| An@(d, ix) | 110 | register number | X | Х | Х | X | |
| xxx W | 111 | 000 | X | X | X | × | |
| xxx L | 111 | 001 | X | Х | Х | Х | |
| PC@(d) | 111 | 010 | Х | Х | X | _ | |
| PC@(d, ix) | 111 | 011 | × | X | Х | _ | |
| #xxx | 111 | 100 | Х | x | - | - | |

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TABLE 22 - INSTRUCTION SET

| Mnemonic | Description | Operation | | | | ion s | |
|-------------|--------------------------------------|---|----|----|----|----------|---|
| | | with Extend (Destination) 10 + (Source) → Destination (Destination) + (Source) → Destination (Destination) + (Source) → Destination (Destination) + (Destination) (Destination) + (Destination) (Destination) + (Destination) (Destination) + (Destination) (Destination) + (Destination) (Destination) + (Destination) (Destination) + (Destination) (Destination) + (Destination) (Destination) + (Destination) (Destination) + (Destination) (Destination) + (Destination) (Destination) + (Destination) (Destination) + (Destination) (Destination) + (Destination) (Destination) + (Destination) + (Destination) + (Destination) + (Destination) + (Destination) (Destination) + (Destination) + (Destination) + (Destination) + (Destination) + (Destination) + (Destination) (Destination) + (Dest | X | N | Z | ٧ | С |
| ABCD | Add Decimal with Extend | (Destination) ₁₀ +(Source) ₁₀ → Destination | T | U | • | U | • |
| ADD | Add Binary | (Destination) + (Source) → Destination | 1. | 1 | • | • | • |
| ADDA | Add Address | (Destination) + (Source) → Destination | - | - | - | - | - |
| ADDI | Add Immediate | (Destination) + Immediate Data → Destination | • | • | • | • | • |
| ADDQ | Add Quick | (Destination) + Immediate Data → Destination | 1. | • | • | • | • |
| ADDX | Add Extended | (Destination) + (Source) + X → Destination | 1. | • | • | ٠ | • |
| AND | AND Logical | (Destination) Λ (Source) → Destination | 7- | • | • | 0 | 0 |
| ANDI | AND Immediate | (Destination) Λ Immediate Data → Destination | 7- | • | • | 0 | 0 |
| ASL, ASR | Arithmetic Shift | (Destination) Shifted by < count> → Destination | 1. | • | • | ٠ | • |
| BCC | Branch Conditionally | If CC then PC+d→PC | 1- | - | - | _ | _ |
| BCHG | Test a Bit and Change | ~(<bit number="">) OF Destination →</bit> | - | - | | - | - |
| BCLR | Test a Bit and Clear | ~(bit number>) OF Destination → Z | 1 | L | ٠ | _ | - |
| BRA | Branch Always | $PC + d \longrightarrow PC$ | - | - | - | - | - |
| BSET | Test a Bit and Set | | - | - | • | - | - |
| BSR | Branch to Subroutine | $PC \rightarrow SP@-, PC+d \rightarrow PC$ | | - | - | - | - |
| BTST | Test a Bit | ~(bit number>) OF Destination → Z | - | - | | - | - |
| СНК | Check Register against Bounds | If Dn <0 or Dn> (<ea>) then TRAP</ea> | T- | | U | U | C |
| CLR | Clear an Operand | 0 → Destination | T- | 0 | 1 | 0 | 0 |
| CMP | Compare | (Destination) – (Source) | T- | | | ٠ | • |
| CMPA | Compare Address | (Destination) – (Source) | Τ- | • | | ٠ | • |
| CMPI | Compare Immediate | (Destination) - Immediate Data | Τ- | • | • | ٠ | ٠ |
| СМРМ | Compare Memory | (Destination) – (Source) | T- | • | • | ٠ | ٠ |
| DBCC | Test Condition, Decrement and Branch | If \sim CC then Dn – 1 \rightarrow Dn, if Dn \neq – 1 then PC + d \rightarrow PC | Τ- | T- | T- | _ | - |
| DIVS | Signed Divide | (Destination)/(Source) → Destination | T | • | 1. | ٠ | 0 |
| DIVU | Unsigned Divide | (Destination)/(Source) → Destination | T- | ٠ | • | ٠ | 0 |
| EOR | Exclusive OR Logical | (Destination) ⊕ (Source) → Destination | T- | • | • | 0 | 0 |
| EORI | Exclusive OR Immediate | (Destination) ⊕ Immediate Data → Destination | Τ- | ٠ | | 0 | 0 |
| EXG | Exchange Register | Rx ↔ Ry | T- | T- | 1- | _ | - |
| EXT | Sign Extend | (Destination) Sign-extended → Destination | Τ- | • | • | 0 | 0 |
| JMP | Jump | Destination → PC | T- | 1- | 1- | - | - |
| JSR | Jump to Subroutine | PC → SP@ - , Destination → PC | T- | T- | 1- | - | - |
| LEA | Load Effective Address | Destination → An | 1- | T- | F | - | - |
| LINK | Link and Allocate | $An \rightarrow SP@-, SP \rightarrow An, SP+d \rightarrow SP$ | T- | - | 1- | - | - |
| LSL, LSR | Logical Shift | (Destination) Shifted by < count> → Destination | 1. | | • | 0 | ٠ |
| MOVE | Move Data from Source to Destination | (Source) → Destination | 1- | 1. | 1 | 0 | 0 |
| MOVE to CCR | Move to Condition Code | (Source) → CCR | 1. | 1. | ŀ | • | • |
| MOVE to SR | Move to the Status Register | (Source) → SR | 1. | • | 1. | ٠ | • |

* affected 0 cleared

- unaffected 1 set

U defined

TABLE 22 - INSTRUCTION SET (CONTINUED)

| Mnemonic | Description | Operation | | Condition Codes | | | | | |
|--|------------------------------------|--|------------|--------------------|----------|----|----------|--|--|
| | | | x | | z | | С | | |
| MOVE from SR Move from the Status Register SR → Destination MOVE USP Move User Stack Pointer USP → An. An → USP | | | 1= | - | _ | Ι= | | | |
| MOVE USP | Move User Stack Pointer | USP→An, An→USP | | 1= | <u> </u> | _ | Ι= | | |
| MOVEA | Move Address | (Source) → Destination | - | = | = | - | - | | |
| MOVEM | Move Multiple Registers | Registers → Destination (Source) → Registers | - | - | - | - | - | | |
| MOVEP | Move Peripheral Data | (Source) → Destination | T- | - | - | - | <u> </u> | | |
| MOVEQ | Move Quick | Immediate Data → Destination | | • | • | 0 | 0 | | |
| MULS | Signed Multiply | (Destination)*(Source) → Destination | | | · | 0 | 0 | | |
| MULU | Unsigned Multiply | (Destination)*(Source) → Destination | | • | 1 | 0 | 0 | | |
| NBCD | Negate Decimal with Extend | 0 – (Destination) ₁₀ – X → Destination | • | υ | · | U | • | | |
| NEG | Negate | 0 – (Destination) → Destination | 1. | • | ٠ | ٠ | • | | |
| NEGX | Negate with Extend | 0 – (Destination) – X → Destination | <u> </u> | • | • | ٠ | · | | |
| NOP | No Operation | _ | | - | - | _ | Γ= | | |
| NOT | Logical Complement | ~ (Destination) → Destination | T- | • | • | 0 | 0 | | |
| OR | Inclusive OR Logical | (Destination) v (Source) → Destination | | • | - | 0 | 0 | | |
| ORI | Inclusive OR Immediate | (Destination) v Immediate Data → Destination | | 1 | · | 0 | 0 | | |
| PEA | Push Effective Address | Destination → SP@ - | T - | - | - | - | F | | |
| RESET | Reset External Devices | _ | | - | - | - | Γ- | | |
| ROL, ROR | Rotate (Without Extend) | (Destination) Rotated by < count> → Destination | 1- | • | • | 0 | • | | |
| ROXL, ROXR | Rotate with Extend | (Destination) Rotated by < count> → Destination | 1. | • | • | 0 | · | | |
| RTE | Return from Exception | $SP@ + \rightarrow SR, SP@ + \rightarrow PC$ | 1. | • | • | • | • | | |
| RTR | Return and Restore Condition Codes | $SP@+ \rightarrow CC, SP@+ \rightarrow PC$ | • | • | · | ٠ | · | | |
| RTS | Return from Subroutine | SP@+→PC | - | - | - | - | - | | |
| SBCD | Subtract Decimal with Extend | (Destination) ₁₀ – (Source) ₁₀ – X → Destination | • | U | • | U | • | | |
| SCC | Set According to Condition | If CC then 1's → Destination else 0's → Destination | | _ | - | - | _ | | |
| STOP | Load Status Register and Stop | Immediate Data → SR, STOP | 一 : | | • | • | • | | |
| SUB | Subtract Binary | (Destination) - (Source) → Destination | • | • | • | ٠ | · | | |
| SUBA | Subtract Address | (Destination) – (Source) → Destination | T- | - | - | - | - | | |
| SUBI | Subtract Immediate | (Destination) – Immediate Data → Destination | • | 1 | ٠ | • | · | | |
| SUBQ | Subtract Quick | (Destination) – Immediate Data → Destination | • | • | • | • | • | | |
| SUBX | Subtract with Extend | (Destination) – (Source) – X → Destination | 1. | • | • | • | • | | |
| SWAP | Swap Register Halves | Register [31 16] 	→ Register [15 0] | | • | · | 0 | 0 | | |
| TAS | Test and Set an Operand | (Destination) Tested → CC, 1 → [7] OF Destination | 1- | • | • | 0 | 0 | | |
| TRAP | Trap | PC→SSP@-, SR→SSP@-, (Vector)→PC | T- | - | - | - | _ | | |
| TRAPV | Trap on Overflow | If V then TRAP | 1- | _ | - | - | - | | |
| TST | Test an Operand | (Destination) Tested → CC | T- | · | · | 0 | 0 | | |
| UNLK | Unlink | $An \rightarrow SP, SP@+ \rightarrow An$ | 1- | - | - | _ | - | | |

^{[] =} bit number

^{*} affected 0 cleared U defined - unaffected 1 set

INSTRUCTION EXECUTION TIMES

The following paragraphs contain listings of the instruction execution times in terms of external clock (CLK) periods. In this timing data, it is assumed that both memory read and write cycle times are four clock periods. Any wait states caused by a longer memory cycle must be added to the total instruction time. The number of bus read and write cycles for each instruction is also included with the timing data. This data is enclosed in parenthesis following the execution periods and is shown as (r/w) where r is the number of read cycles and w is the number of write cycles.

NOTE

The number of periods includes instruction fetch and all applicable operand fetches and stores

EFFECTIVE ADDRESS OPERAND CALCULATION TIMING

Table 23 lists the number of clock periods required to compute an instruction's effective address. It includes fetching of any extension words, the address computation, and fetching of the memory operand. The number of bus read and write cycles is shown in parenthesis as (r/w). Note there are no write cycles involved in processing the effective address.

MOVE INSTRUCTION CLOCK PERIODS

Tables 24 and 25 indicate the number of clock periods for the move instruction. This data includes instruction fetch, operand reads, and operand writes. The number of bus read and write cycles is shown in parenthesis as. (r/w)

STANDARD INSTRUCTION CLOCK PERIODS

The number of clock periods shown in Table 26 indicates the time required to perform the operations, store the results, and read the next instruction. The number of bus read and write cycles is shown in parenthesis as (r/w). The number of clock periods and the number of read and write cycles must be added respectively to those of the effective address calculation where indicated.

In Table 26 the headings have the following meanings An = address register operand, Dn = data register operand, ea = an operand specified by an effective address, and M = memory effective address operand

IMMEDIATE INSTRUCTION CLOCK PERIODS

The number of clock periods shown in Table 27 includes the time to fetch immediate operands, perform the operations, store the results, and read the next operation. The number of bus read and write cycles is shown in parenthesis as (r/w). The number of clock periods and the number of read and write cycles must be added respectively to those of the effective address calculation where indicated.

In Table 27, the headings have the following meanings #= immediate operand, Dn= data register operand, An= address register operand, M= memory operand, and SR= status register

SINGLE OPERAND INSTRUCTION CLOCK PERIODS

Table 28 indicates the number of clock periods for the single operand instructions. The number of bus read and write cycles is shown in parenthesis as (r/w). The number of clock periods and the number of read and write cycles must be added respectively to those of the effective address calculation where indicated.

TABLE 23 - EFFECTIVE ADDRESS CALCULATION TIMING

| | Addressing Mode | Byte, Word | Long |
|-------------|--|----------------|-----------------|
| - | Register | | |
| Dn | Data Register Direct | 0 (0/0) | 0 (0/0) |
| An | Address Register Direct | 0 (0/0) | 0 (0/0) |
| | Memory | | |
| An@ | Address Register Indirect | 4(1/0) | 8(2/0) |
| An@ + | Address Register Indirect with Postincrement | 4 (1/0) | 8(2/0) |
| An@ - | Address Register Indirect with Predecrement | 6(1/0) | 10(2/0) |
| An@(d) | Address Register Indirect with Displacement | 8(2/0) | 12 (3/0) |
| An@(d, ix)* | Address Register Indirect with Index | 10(2/0) | 14(3/0) |
| xxx.W | Absolute Short | 8(2/0) | 12 (3/0) |
| xxx.L | Absolute Long | 12(3/0) | 16(4/0) |
| PC@(d) | Program Counter with Displacement | 8(2/0) | 12 (3/0) |
| PC@(d, ix)* | Program Counter with Index | 10(2/0) | 14(3/0) |
| #xxx | Immediate | 4(1/0) | 8(2/0) |

^{*}The size of the index register (ix) does not affect execution time

TABLE 24 — MOVE BYTE AND WORD INSTRUCTION CLOCK PERIODS

| Source | | Destination | | | | | | | | |
|-------------|-----------------|-----------------|-----------------|-----------------|-----------------|-----------------|-----------------|-----------------|-----------------|--|
| Source | Dn | An | An@ | An@ + | An@ - | An@(d) | An@(d,ix)* | xxx.W | xxx.L | |
| Dn | 4(1/0) | 4(1/0) | 8(1/1) | 8(1/1) | 8(1/1) | 12 (2/1) | 14(2/1) | 12 (2/1) | 16 (3/1) | |
| An | 4(1/0) | 4(1/0) | 8(1/1) | 8(1/1) | 8(1/1) | 12 (2/1) | 14(2/1) | 12 (2/1) | 16 (3/1) | |
| An@ | 8(2/0) | 8 (2/0) | 12 (2/1) | 12 (2/1) | 12 (2/1) | 16 (3/1) | 18(3/1) | 16 (3/1) | 20(4/1) | |
| An@ + | 8(2/0) | 8(2/0) | 12(2/1) | 12 (2/1) | 12 (2/1) | 16 (3/1) | 18 (3/1) | 16 (3/1) | 20(4/1) | |
| An@ | 10(2/0) | 10 (2/0) | 14(2/1) | 14(2/1) | 14(2/1) | 18 (3/1) | 20(3/1) | 18 (3/1) | 22(4/1) | |
| An@(d) | 12 (3/0) | 12 (3/0) | 16 (3/1) | 16 (3/1) | 16 (3/1) | 20(4/1) | 22(4/1) | 20(4/1) | 24 (5/1) | |
| An@(d, ix)* | 14(3/0) | 14(3/0) | 18 (3/1) | 18(3/1) | 18 (3/1) | 22(4/1) | 24(4/1) | 22(4/1) | 26 (5/1) | |
| xxx.W | 12 (3/0) | 12 (3/0) | 16 (3/1) | 16 (3/1) | 16 (3/1) | 20 (4/1) | 22(4/1) | 20(4/1) | 24 (5/1) | |
| xxx.L | 16 (4/0) | 16 (4/0) | 20(4/1) | 20(4/1) | 20 (4/1) | 24 (5/1) | 26(5/1) | 24 (5/1) | 28 (6/1) | |
| PC@(d) | 12(3/0) | 12 (3/0) | 16 (3/1) | 16 (3/1) | 16 (3/1) | 20(4/1) | 22(4/1) | 20(4/1) | 24(5/1) | |
| PC@(d, ix)* | 14(3/0) | 14(3/0) | 18 (3/1) | 18 (3/1) | 18 (3/1) | 22(4/1) | 24(4/1) | 22(4/1) | 26 (5/1) | |
| #xxx | 8(2/0) | 8 (2/0) | 12 (2/1) | 12 (2/1) | 12(2/1) | 16 (3/1) | 18(3/1) | 16 (3/1) | 20(4/1) | |

The size of the index register (ix) does not affect execution time

TABLE 25 - MOVE LONG INSTRUCTION CLOCK PERIODS

| | | Destination | | | | | | | | |
|-------------|-----------------|-----------------|-----------------|-----------------|-----------------|-----------------|-----------------|-----------------|-----------------|--|
| Source | Dn | An | An@ | An@ + | An@ | An@(d) | An@(d,ix)* | xxx.W | xxx.L | |
| Dn | 4(1/0) | 4(1/0) | 12 (1/2) | 12 (1/2) | 14(1/2) | 16(2/2) | 18(2/2) | 16(2/2) | 20 (3/2) | |
| An | 4(1/0) | 4(1/0) | 12 (1/2) | 12 (1/2) | 14 (1/2) | 16 (2/2) | 18(2/2) | 16(2/2) | 20(3/2) | |
| An@ | 12 (3/0) | 12 (3/0) | 20 (3/2) | 20 (3/2) | 20 (3/2) | 24 (4/2) | 26 (4/2) | 24 (4/2) | 28 (5/2) | |
| An@+ | 12(3/0) | 12 (3/0) | 20 (3/2) | 20(3/2) | 20 (3/2) | 24(4/2) | 26 (4/2) | 24 (4/2) | 28 (5/2) | |
| An@ | 14(3/0) | 14(3/0) | 22 (3/2) | 22 (3/2) | 22 (3/2) | 26(4/2) | 28 (4/2) | 26 (4/2) | 30 (5/2) | |
| An@(d) | 16(4/0) | 16 (4/0) | 24 (4/2) | 24 (4/2) | 24 (4/2) | 28 (5/2) | 30 (5/2) | 28 (5/2) | 32 (6/2) | |
| An@(d, ix)* | 18(4/0) | 18(4/0) | 26 (4/2) | 26 (4/2) | 26 (4/2) | 30(5/2) | 32 (5/2) | 30 (5/2) | 34 (6/2) | |
| xxx.W | 16(4/0) | 16 (4/0) | 24 (4/2) | 24 (4/2) | 24 (4/2) | 28(5/2) | 30 (5/2) | 28 (5/2) | 32 (6/2) | |
| xxx.L | 20 (5/0) | 20 (5/0) | 28 (5/2) | 28 (5/2) | 28 (5/2) | 32(6/2) | 34 (6/2) | 32 (6/2) | 36 (7/2) | |
| PC@(d) | 16(4/0) | 16(4/0) | 24 (4/2) | 24 (4/2) | 24 (4/2) | 28(5/2) | 30 (5/2) | 28 (5/2) | 32 (5/2) | |
| PC@(d, ix)* | 18(4/0) | 18 (4/0) | 26 (4/2) | 26 (4/2) | 26 (4/2) | 30 (5/2) | 32 (5/2) | 30 (5/2) | 34 (6/2) | |
| #xxx | 12(3/0) | 12 (3/0) | 20 (3/2) | 20 (3/2) | 20 (3/2) | 24 (4/2) | 26 (4/2) | 24 (4/2) | 28(5/2) | |

^{*}The size of the index register (ix) does not affect execution time

TABLE 26 - STANDARD INSTRUCTION CLOCK PERIODS

| Instruction | Size | op < ea>, An | op <ea>, Dn</ea> | op Dn, < M> |
|-------------|------------|--------------|----------------------|-------------------|
| | Byte, Word | 8(1/0)+ | 4(1/0) + | 8(1/1)+ |
| ADD | Long | 6(1/0) + ** | 6(1/0) + ** | 12 (1/2) + |
| | Byte, Word | _ | 4 (1/0) + | 8(1/1)+ |
| AND | Long | _ | 6(1/0) + ** | 12(1/2)+ |
| | Byte, Word | 6(1/0)+ | 4 (1/0) + | _ |
| СМР | Long | 6(1/0)+ | 6(1/0)+ | |
| DIVS | | _ | 158 (1/0) + * | _ |
| DIVU | _ | _ | 140 (1/0) + * | _ |
| | Byte, Word | | 4(1/0)*** | 8(1/1)+ |
| EOR | Long | _ | 8(1/0)*** | 12 (1/2)+ |
| MULS | | | 70 (1/0) + * | |
| MULU | _ | _ | 70 (1/0) + * | _ |
| | Byte, Word | _ | 4(1/0)+ | 8(1/1)+ |
| OR | Long | _ | 6(1/0) + ** | 12(1/1)+ |
| SUD. | Byte, Word | 8(1/0)+ | 4(1/0)+ | 8(1/1)+ |
| SUB | Long | 6(1/0) + ** | 6(1/0) + ** | 12 (1/2) + |

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TABLE 27 - IMMEDIATE INSTRUCTION CLOCK PERIODS

| Instruction | Size | op #, Dn | op #, An | op #, M |
|-------------|------------|-----------------|----------|-------------------|
| ADDI | Byte, Word | 8(2/0) | _ | 12(2/1)+ |
| ADDI | Long | 16(3/0) | _ | 20 (3/2) + |
| ADDQ | Byte, Word | 4(1/0) | 8(1/0)* | 8(1/1)+ |
| ADDO | Long | 8(1/0) | 8(1/0) | 12 (1/2) + |
| ANDI | Byte, Word | 8(2/0) | _ | 12 (2/1) + |
| | Long | 16(3/0) | _ | 20(3/1)+ |
| СМРІ | Byte, Word | 8(2/0) | 8(2/0) | 8 (2/0) + |
| CIVIFI | Long | 14(3/0) | 14(3/0) | 12 (3/0) + |
| EORI | Byte, Word | 8(2/0) | _ | 12(2/1) + |
| LOM | Long | 16 (3/0) | _ | 20 (3/2) + |
| MOVEQ | Long | 4(1/0) | - | _ |
| ORI | Byte, Word | 8(2/0) | - | 12(2/1)+ |
| Oni | Long | 16 (3/0) | _ | 20 (3/2) + |
| SUBI | Byte, Word | 8(2/0) | _ | 12 (2/1)+ |
| 3081 | Long | 16 (3/0) | - | 20(3/2) + |
| SUBQ | Byte, Word | 4(1/0) | 8(1/0)* | 8(1/1)+ |
| 3080 | Long | 8(1/0) | 8(1/0) | 12 (1/2) + |

⁺ add effective address calculation time

TABLE 28 — SINGLE OPERAND INSTRUCTION CLOCK PERIODS

| Instruction | Size | Register | Memory |
|-------------|-------------|----------------|-------------------|
| CI D | Byte, Word | 4(1/0) | 8(1/1)+ |
| CLR | Long | 6(1/0) | 12 (1/2)+ |
| NBCD | Byte | 6(1/0) | 8(1/1)+ |
| 1150 | Byte, Word | 4(1/0) | 8(1/1)+ |
| NEG | Long | 6(1/0) | 12 (1/2) + |
| NEON | Byte, Word | 4(1/0) | 8(1/1)+ |
| NEGX | Long | 6(1/0) | 12 (1/2)+ |
| NOT | Byte, Word | 4(1/0) | 8(1/1)+ |
| NOT | Long | 6 (1/0) | 12 (1/2) + |
| | Byte, False | 4(1/0) | 8(1/1)+ |
| scc | Byte, True | 6 (1/0) | 8(1/1)+ |
| TAS | Byte | 4(1/0) | 10(1/1)+ |
| TOT. | Byte, Word | 4(1/0) | 4(1/0) |
| TST | Long | 4(1/0) | 4(1/0)+ |

⁺ add effective address calculation time

SHIFT/ROTATE INSTRUCTION CLOCK PERIODS

Table 29 indicates the number of clock periods for the shift and rotate instructions. The number of bus read and write cycles is shown in parenthesis as. (r/w). The number of clock periods and the number of read and write cycles must be added respectively to those of the effective address calculation where indicated.

BIT MANIPULATION INSTRUCTION CLOCK PERIODS

Table 30 indicates the number of clock periods required for the bit manipulation instructions. The number of bus read and write cycles is shown in parenthesis as: (r/w). The number of clock periods and the number of read and write cycles must be added respectively to those of the effective address calculation where indicated.

CONDITIONAL INSTRUCTION CLOCK PERIODS

Table 31 indicates the number of clock periods required for the conditional instructions. The number of bus read and write cycles is indicated in parenthesis as: (r/w). The number of clock periods and the number of read and write cycles must be added respectively to those of the effective address calculation where indicated.

JMP, JSR, LEA, PEA, MOVEM INSTRUCTION CLOCK PERIODS

Table 32 indicates the number of clock periods required for the jump, jump to subroutine, load effective address, push effective address, and move multiple registers instructions. The number of bus read and write cycles is shown in parenthesis as: (r/w).

^{*}word only

TABLE 29 — SHIFT/ROTATE INSTRUCTION CLOCK PERIODS

| Instruction | Size | Register | Memory |
|-------------|------------|-------------|---------|
| 400 401 | Byte, Word | 6 + 2n(1/0) | 8(1/1)+ |
| ASR, ASL | Long | 8 + 2n(1/0) | _ |
| 100 101 | Byte, Word | 6 + 2n(1/0) | 8(1/1)+ |
| LSR, LSL | Long | 8 + 2n(1/0) | |
| DOD DOL | Byte, Word | 6 + 2n(1/0) | 8(1/1)+ |
| ROR, ROL | Long | 8 + 2n(1/0) | _ |
| DOVD DOVI | Byte, Word | 6 + 2n(1/0) | 8(1/1)+ |
| ROXR, ROXL | Long | 8 + 2n(1/0) | _ |

TABLE 30 - BIT MANIPULATION INSTRUCTION CLOCK PERIODS

| l4 | Size | Dyn | amic | Static | |
|-------------|------|------------------|---------|------------------|-------------------|
| Instruction | Size | Register | Memory | Register | Memory |
| | Byte | _ | 8(1/1)+ | _ | 12 (2/1) + |
| BCHG | Long | 8(1/0)* | - | 12(2/0)* | _ |
| | Byte | _ | 8(1/1)+ | _ | 12 (2/1)+ |
| BCLR | Long | 10 (1/0)* | | 14(2/0)* | _ |
| | Byte | _ | 8(1/1)+ | _ | 12(2/1)+ |
| BSET | Long | 8(1/0)* | _ | 12 (2/0)* | _ |
| BTST | Byte | _ | 4(1/0)+ | _ | 8 (2/0) + |
| | Long | 6 (1/0) | _ | 10 (2/0) | _ |

⁺ add effective address calculation time

TABLE 31 — CONDITIONAL INSTRUCTION CLOCK PERIODS

| Instruction | Displacement | Trap or Branch Taken | Trap or Branch Not Taken |
|-------------|--------------|-------------------------|-----------------------------|
| BCC | Byte | 10(2/0) | 8(1/0) |
| | Word | 10(2/0) | 12 (2/0) |
| | Byte | 10(2/0) | |
| BRA | Word | 10(2/0) | - |
| non | Byte | 18(2/2) | _ |
| BSR | Word | 18(2/2) | |
| DD | CC true | | 12 (2/0) |
| DBCC | CC false | 10 (2/0) | 14(3/0) |
| СНК | | 40 (5/3) + * | 8(1/0)+ |
| TRAP | - | 34 (4/3) | **** |
| TRAPV | _ | 34 (5/3) | 4(1/0) |

⁺ add effective address calculation time

^{*} indicates maximum value

^{*} indicates maximum value

TABLE 32 - JMP, JSR, LEA, PEA, MOVEM INSTRUCTION CLOCK PERIODS

| Instr | Size | An@ | An@+ | An@ - | An@(d) | An@(d, ix) * | xxx.W | xxx.L | PC@(d) | PC@(d, ix)* |
|----------|--------|------------|------------|---------|-----------------|--------------|------------|-----------------|------------|-----------------|
| JMF | | 8(2/0) | _ | | 10 (2/0) | 14(3/0) | 10(2/0) | 12(3/0) | 10(2/0) | 14(3/0) |
| JSR | - | 16(2/2) | _ | _ | 18(2/2) | 22(2/2) | 18(2/2) | 20(3/2) | 18(2/2) | 22(2/2) |
| LEA | _ | 4(1/0) | _ | _ | 8(2/0) | 12(2/0) | 8(2/0) | 12(3/0) | 8(2/0) | 12 (2/0) |
| PEA | | 12(1/2) | _ | _ | 16(2/2) | 20(2/2) | 16(2/2) | 20 (3/2) | 16(2/2) | 20(2/2) |
| MOVEM | Word | 12 + 4n | 12 + 4n | _ | 16 + 4n | 18 + 4n | 16 + 4n | 20 + 4n | 16 + 4n | 18 + 4n |
| | ***** | (3 + n/0) | (3+n/0) | - | (4 + n/0) | (4 + n/0) | (4+n/0) | (5 + n/0) | (4+n/0) | (4 + n/0) |
| M -R | Long | 12 + 8n | 12 + 8n | _ | 16 + 8n | 18 + 8n | 16 + 8n | 20 + 8n | 16 + 8n | 18 + 8n |
| W - N | cong | (3 + 2n/0) | (3 + 2n/0) | | (4 + 2n/0) | (4 + 2n/0) | (4 + 2n/0) | (5 + 2n/0) | (4 + 2n/0) | (4 + 2n/0) |
| MOVEM | Word | 8 + 5n | | 8 + 5n | 12 + 5n | 14 + 5n | 12 + 5n | 16 + 5n | _ | _ |
| WIO VEIN | ****** | (2/n) | - | (2/n) | (3/n) | (3/n) | (3/n) | (4/n) | - | _ |
| RM | Long | 8 + 10n | | 8 + 10n | 12 + 10n | 14 + 10n | 12+10n | 16 + 10n | _ | - |
| n IWI | Long | (2/2n) | - 1 | (2/2n) | (3/2n) | (3/2n) | (3/2n) | (4/2n) | _ | _ |

n is the number of registers to move

MULTI-PRECISION INSTRUCTION CLOCK PERIODS

Table 33 indicates the number of clock periods for the multi-precision instructions. The number of clock periods in cludes the time to fetch both operands, perform the operations, store the results, and read the next instructions. The

number of read and write cycles is shown in parenthesis as: (r/w).

In Table 33, the headings have the following meanings Dn = data register operand and M = memory operand

TABLE 33 - MULTI-PRECISION INSTRUCTION CLOCK PERIODS

| Instruction | Size | op Dn, Dn | op M, M |
|-------------|------------|-----------|-----------------|
| ADDX | Byte, Word | 4(1/0) | 18 (3/1) |
| | Long | 8(1/0) | 30 (5/2) |
| СМРМ | Byte, Word | | 12(3/0) |
| CIVIFIVI | Long | _ | 20(5/0) |
| SUBX | Byte, Word | 4(1/0) | 18(3/1) |
| 3087 | Long | 8(1/0) | 30(5/2) |
| ABCD | Byte | 6(1/0) | 18 (3/1) |
| SBCD | Byte | 6(1/0) | 18 (3/1) |

MISCELLANEOUS INSTRUCTION CLOCK PERIODS

Table 34 indicates the number of clock periods for the following miscellaneous instructions. The number of bus read and write cycles is shown in parenthesis as: (r/w). The number of clock periods plus the number of read and write cycles must be added to those of the effective address calculation where indicated.

EXCEPTION PROCESSING CLOCK PERIODS

Table 35 indicates the number of clock periods for exception processing. The number of clock periods includes the time for all stacking, the vector fetch, and the fetch of the first instruction of the handler routine. The number of bus read and write cycles is shown in parenthesis as: (r/w).

^{*} is the size of the index register (ix) does not affect the instruction's execution time

TABLE 34 — MISCELLANEOUS INSTRUCTION CLOCK PERIODS

| Instruction | Size | Register | Memory | Register - Memory | Memory - Register |
|---------------|------|------------------|-------------------|-------------------|-------------------|
| MOVE from SR | _ | 6(1/0) | 8(1/1)+ | _ | _ |
| MOVE to CCR | _ | 12 (2/0) | 12(2/0) + | | - |
| MOVE to SR | _ | 12 (2/0) | 12 (2/0) + | _ | _ |
| | Word | _ | _ | 16(2/2) | 16 (4/0) |
| MOVEP | Long | _ | _ | 24 (2/4) | 24(6/0) |
| EXG | _ | 6(1/0) | _ | _ | - |
| EVT | Word | 4(1/0) | _ | _ | _ |
| EXT | Long | 4(1/0) | _ | _ | |
| LINK | _ | 16(2/2) | _ | _ | _ |
| MOVE from USP | _ | 4(1/0) | _ | _ | _ |
| MOVE to USP | _ | 4(1/0) | | - | _ |
| NOP | _ | 4(1/0) | _ | _ | _ |
| RESET | _ | 132 (1/0) | _ | _ | _ |
| RTE | _ | 20(5/0) | T - | | _ |
| RTR | _ | 20 (5/0) | _ | | - |
| RTS | _ | 16(4/0) | _ | - | - |
| STOP | _ | 4(0/0) | _ | _ | _ |
| SWAP | _ | 4(1/0) | _ | - | |
| UNLK | _ | 12(3/0) | _ | _ | _ |

⁺ add effective address calculation time

TABLE 35 - EXCEPTION PROCESSING CLOCK PERIODS

| Exception | Periods |
|------------------------|------------------|
| Address Error | 50(4/7) |
| Bus Error | 50(4/7) |
| Interrupt | 44 (5/3)* |
| Illegal Instruction | 34 (4/3) |
| Privileged Instruction | 34 (4/3) |
| Trace | 34 (4/3) |

^{*}The interrupt acknowledge bus cycle is assumed to take four external clock periods



MC68120 MC68121 (1.0 MHz) (1.0 MHz) MC68120-1 MC68121-1 (1.25 MHz) (1.25 MHz)

Advance Information

INTELLIGENT PERIPHERAL CONTROLLER

The MC68120/MC68121 Intelligent Peripheral Controller (IPC) is a general purpose, mask programmable peripheral controller. The IPC provides the interface between an M68000 or M6800 Family microprocessor and the final peripheral devices through a system bus and control lines. System bus data is transferred to and from the IPC via dual-port RAM while the software utilizes the semaphore registers to control RAM tasking or any other shared resource. Multiple operating modes range from a single chip mode with 21 I/O lines and 2 control lines to an expanded mode supporting an address space of 64K bytes. The MC68120 has 2K bytes of on-chip ROM to make full use of all operating modes. The MC68121 utilizes only the expanded address modes, due to the absence of on-chip ROM.

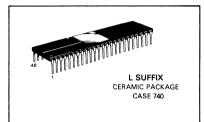
A serial communications interface, 16-bit timer, dual-ported RAM and semaphore registers are available for use by the IPC in all operating modes.

- System Bus Compatible with the Asynchronous M68000 Family
- System Bus Compatible with the MC6809 and Other M6800 Family Processors/Peripherals
- Local Bus Allows Interface with all M6800 Peripherals
- MC6801 Source and Object Code Compatible
- Upward Compatible with MC6800 Source and Object Code
- 2048 Bytes of ROM (MC68120 Only)
- 128 Bytes of Dual-Ported RAM
- Multiple Operation Modes Ranging from Single Chip to Expanded, with 64K Byte Address Space
- Six Shared Semaphore Registers
- 21 Parallel I/O Lines and 2 Handshake Lines (5 I/O Lines on MC68121)
- Serial Communications Interface (SCI)
- 16-Bit Three-Function Timer
- 8-Bit CPU and Internal Bus
- Halt/Bus Available Capability Control
- 8×8 Multiply Instruction
- TTL Compatible Inputs and Outputs
- External and Internal Interrupts

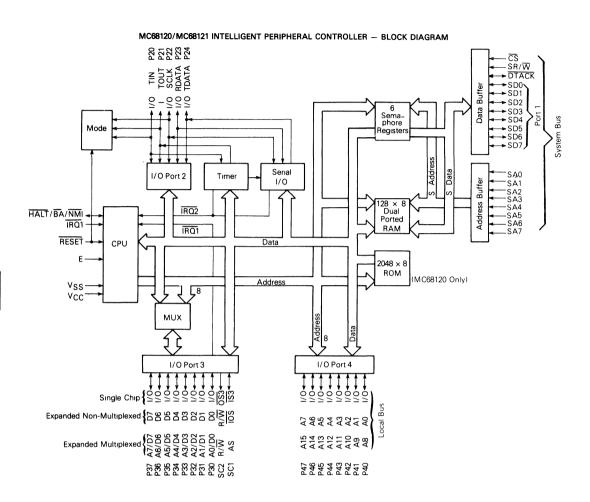
HMOS

(HIGH-DENSITY N-CHANNEL SILICON-GATE)

INTELLIGENT PERIPHERAL CONTROLLER



PIN ASSIGNMENT Vss d1 48 RESET IRQ1 d2 47 P24 HALT/ d3 46 P23 E **[**]4 45 P22 SR/W 15 44 P21 DTACK C6 43 P20 टड पे 42 DSC2 41 SC1 SA7 **□**8 SA6 **П**9 40 P30 SA5 10 39DP31 SA4 **1**11 38 P32 37D P33 Vac **□**12 SA3 13 36 P34 35**D** P35 SA2 114 SA1 15 34 D P36 SA0 116 33D P37 SD0 17 32DP40 SD1 118 31DP41 30DP42 SD2 19 29 P43 SD3 20 28 P44 SD4 **2**1 27 P45 SD5 22 SD6 23 26 P46 SD7 **[**24 25**口** P47



MAXIMUM RATINGS

| Rating | Symbol | Value | Unit |
|-----------------------------|------------------|-------------|------|
| Supply Voltage | Vcc | -03 to +70 | ٧ |
| Input Voltage | V _{in} | -03 to +70 | ٧ |
| Operating Temperature Range | TA | 0 to 70 | °C |
| Storage Temperature Range | T _{stg} | -55 to +150 | °C |

THERMAL CHARACTERISTICS

| Characteristic | Symbol | Value | Rating |
|--------------------|---------------|-------|--------|
| Thermal Resistance | | | |
| Ceramic Package | θ_{JA} | 50 | °C/W |

This device contains circuitry to protect the inputs against damage due to high static voltages or electric fields, however, it is advised that normal precautions be taken to avoid application of any voltage higher than maximum rated voltages to this high-impedance circuit. For proper operation it is recommended that V_{In} and V_{Out} be constrained to the range $V_{SS} \! \leq \! (V_{In})$ or $V_{Out} \! \leq \! V_{CC}$

Unused inputs must always be tied to an appropriate logic voltage level (e.g., either VSS or VCC)

POWER CONSIDERATIONS

The average chip-junction temperature, TJ, in °C can be obtained from

$$T_{J} = T_{A} + (P_{D} \bullet \theta_{JA}) \tag{1}$$

Where

T_A ≡ Ambient Temperature, °C

 $\theta_{JA} \equiv Package Thermal Resistance, Junction-to-Ambient, °C/W$

PD = PINT + PPORT

 $P_{INT} \equiv I_{CC} \times V_{CC}$, Watts - Chip Internal Power

PPORT = Port Power Dissipation, Watts - User Determined

For most applications $PPORT \blacktriangleleft PINT$ and can be neglected PPORT may become significant if the device is configured to drive Darlington bases or sink LED loads

An approximate relationship between PD and TJ (if PPORT is neglected) is

 $P_D = K - (T_{.1} + 273 ^{\circ}C)$

(2)

Solving equations 1 and 2 for K gives

 $K = P_D \bullet (T_A + 273 \circ C) + \theta_{JA} \bullet P_D^2$

Where K is a constant pertaining to the particular part. K can be determined from equation 3 by measuring P_D (at equilibrium) for a known T_A . Using this value of K the values of P_D and T_J can be obtained by solving equations (1) and (2) iteratively for any value of T_A .

DC LOCAL BUS ELECTRICAL CHARACTERISTICS ($V_{CC}=5.0 \text{ Vdc} \pm 5\%$, $V_{SS}=0$, $T_A=0^{\circ}$ to 70°C unless otherwise noted) (Refer to Figures 1 and 2)

| Characteristic | | Symbol | Min | Тур | Max | Unit |
|--|---|-------------------|---|-------------|------------------------|------|
| Input High Voltage | E | VEIH | V _{CC} - 0 75 | - | Vcc | ٧ |
| Input Low Voltage | E | VEIL | V _{SS} -03 | | Vss+06 | ٧ |
| Input High Voltage | RESET Other Inputs* | · V _{IH} | V _{SS} +40 V _{SS} +20 | - | V _{CC} VCC | ٧ |
| Input Low Voltage | All Inputs* | VIL | Vss-03 | - | V _{SS} +08 | ٧ |
| Input Load Current (V _{In} = 0 to 2 4 V) | Port 4 SC1 | l _{in} | _ | - | 05 08 | mA |
| Input Leakage Current (V _{In} = 0 to 5 25 V) | HALT/NMI, IRQ1, RESET | l _{in} | _ | ۱5 | 2 5 | μΑ |
| Three-State (Off State) Input Current (V _{IN} = 0 5 to 2 4 V) | SD0-SD7, P30-P37 P20-P24 | ITSI | _ _ | 2 0 10 0 | 10 100 | μΑ |
| Output High Voltage $ \begin{aligned} &(I_{lOad} = -205\mu\text{A, V}_{CC} = \text{min}) \\ &(I_{lOad} = -145\mu\text{A, V}_{CC} = \text{min}) \\ &(I_{lOad} = -100\mu\text{A, V}_{CC} = \text{min}) \end{aligned} $ | P30-P37 P40-P47, SC1, SC2 Other Outputs | V _{ОН} | V _{SS} +24 V _{SS} +24 V _{SS} +24 | | - - - | ٧ |
| Output Low Voltage (I _{load} = 2 0 mA, V _{CC} = min) | All Outputs | VOL | _ | - | V _{SS} +05 | ٧ |
| Internal Power Dissipation (measured at TA = 0°C) | | PINT | _ | - | 1200 | mW |
| Input Capacitance $(V_{IN} = 0, T_A = 25$ °C, $f_O = 1.0$ MHz) | P30-P37, P40-P47, SC1 Other Inputs | C _{in} | | 1 1 | 12 5 10 0 | pF |

^{*}Except Mode Programming Levels, See Figure 31

FIGURE 1 - CMOS LOAD

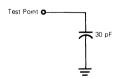
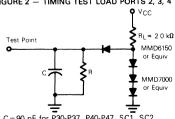


FIGURE 2 — TIMING TEST LOAD PORTS 2, 3, 4



C = 90 pF for P30-P37, P40-P47, SC1, SC2 = 30 pF for P20-P24, HALT/BA/NMI

 $R = 16.5 \text{ k}\Omega$ for P40-P47, SC1, SC2

= 12 k Ω for P30-P37

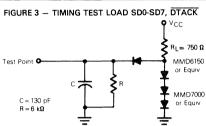
= 24 k Ω for P20-P24, $\overline{HALT}/\overline{BA}/\overline{NMI}$

MC68120•MC68121•MC68120-1•MC68121-1

DC SYSTEM BUS ELECTRICAL CHARACTERISTICS

(V_{CC}=5 0 Vdc \pm 5%, VSS=0, TA=70°C unless otherwise noted) (Refer to Figure 3)

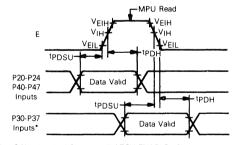
| | Characteristic | | Symbol | Min | Тур | Max_ | Unit |
|--|---------------------------|--|-----------------|---------------------|-----|---------------------|------|
| Input High Voltage | CS, DTACK, S | A0-SA7, SD0-SD7, SR/ $\overline{\mathbb{W}}$ | V _{IH} | V _{SS} +20 | - | Vcc | ٧ |
| Input Low Voltage | CS, DTACK, S | A0-SA7, SD0-SD7, SR/W | VIL | V _{SS} -03 | _ | V _{SS} +08 | ٧ |
| Output High Voltage (I _{Load} = -400 μ) | A, V _{CC} = min) | DTACK, SD0-SD7 | Voн | V _{SS} +24 | - | _ | V |
| Output Low Voltage (ILoad = 5 3 mA, | V _{CC} = min) | DTACK, SD0-SD7 | VOL | _ | _ | V _{SS} +05 | ٧ |



PERIPHERAL PORT TIMING (Refer to Figures 4 through 7)

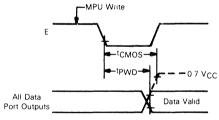
| Characteristics | Symbol | Min | Max | Unit |
|---|------------------|-----|-----|------|
| Peripheral Data Setup Time | tPDSU | 200 | _ | ns |
| Peripheral Data Hold Time | ^t PDH | 200 | _ | ns |
| Delay Time, Enable Positive Transition to OS3 Negative Transition | tOSD1 | | 350 | ns |
| Delay Time, Enable Positive Transition to OS3 Positive Transition | tOSD2 | _ | 350 | ns |
| Delay Time, Enable Negative Transition to Peripheral Data Valid (Ports 2, 3, 4) | tPWD | _ | 350 | ns |
| Delay Time, Enable Negative Transition to Peripheral CMOS Data Valid | tcmos | _ | 20 | μS |
| Input Strobe Pulse Width | tpWIS | 200 | | ns |
| Input Data Hold Time | ЧH | 50 | _ | ns |
| Input Data Setup Time | tis | 20 | - | ns |
| Input Capture Pulse Width (Timer Function) | tpWIC | 2 | _ | Ecyc |

FIGURE 4 — DATA SETUP AND HOLD TIMES (MPU READ LOCAL BUS)



*Port 3 Non-Latched Operation (LATCH ENABLE = 0)

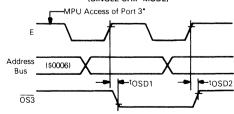
FIGURE 5 — DATA SETUP AND HOLD TIMES (MPU WRITE LOCAL BUS)



Notes

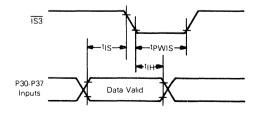
- 1 10 k Pullup resistor required for Port 2 to reach 0.7 $\rm V_{CC}$
- 2 Not applicable to P21
- 3 Port 4 cannot be pulled above V_{CC}

FIGURE 6 — PORT 3 OUTPUT STROBE TIMING (SINGLE CHIP MODE)



*Access matches Output Strobe Select (OSS=0, a read, OSS=1, a write)

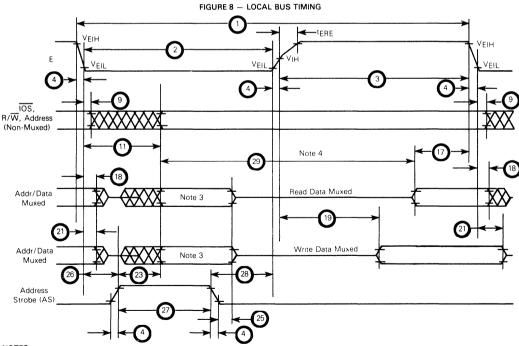
FIGURE 7 — PORT 3 LATCH TIMING (SINGLE CHIP MODE)



Note Timing measurements are referenced to and from a low voltage of 0.8 volts and a high voltage of 2.0 volts, unless otherwise noted

LOCAL BUS TIMING (See Notes 1 and 2)

| Ident. | Characteristics | Symbol | MC68120/ MC68121 | | MC68120-1/ MC68121-1 | | Unit |
|--------|------------------------------|---------------------------------|---------------------|------|-------------------------|------|------|
| Number | | | Min | Max | Mın | Max | |
| 1 | Cycle Time | t _{cyc} | 10 | 20 | 0.8 | 2 0 | μS |
| 2 | Pulse Width, E Low | PWEL | 430 | 1000 | 360 | 1000 | ns |
| 3 | Pulse Width, E High | PWEH | 450 | 1000 | 360 | 1000 | ns |
| 4 | Clock Rise and Fall Time | t _r , t _f | | 25 | _ | 25 | ns |
| 9 | Non-Muxed Address Hold Time | tAH | 20 | _ | 20 | - | ns |
| 11 | Address Delay From E Low | tAD | - | 260 | - | 220 | ns |
| 17 | Read Data Setup Time | †DSR | 80 | _ | 70 | - | ns |
| 18 | Read Data Hold Time | †DHR | 10 | _ | 10 | - | ns |
| 19 | Write Data Delay Time | tDDW | _ | 225 | _ | 200 | ns |
| 21 | Write Data Hold Time | tDHW | 20 | _ | 20 | | ns |
| 23 | Muxed Address Delay from AS | tADM | - | 90 | _ | 70 | ns |
| 25 | Muxed Address Hold Time | tAHL | 20 | 110 | 20 | 110 | ns |
| 26 | Delay Time E to AS Rise | tASD | 100 | - | 80 | - | ns |
| 27 | Pulse Width, AS High | PWASH | 220 | _ | 170 | - | ns |
| 28 | Delay Time AS to E Rise | tASED | 100 | _ | 80 | _ | ns |
| 29 | Usable Access Time (Note 9) | tACC | 570 | _ | 435 | - | ns |
| | Enable Rise Time Extended | tERE | - | 80 | - | 80 | ns |
| | Processor Control Setup Time | tPCS | 200 | _ | 200 | - | ns |
| | Processor Control Hold Time | ^t PCH | 20 | 40 | 20 | 40 | ns |



NOTES

- Voltage levels shown are V_L≤0 5 V, V_H≥2 4 V, unless otherwise specified
 Measurement points shown are 0 8 V and 2 0 V, unless otherwise specified

- Address valid on the occurrence of the latest of 11 or 23
 Usable access time is computed by 1 (4+11+17), see note 8

| ASYNCHRONOUS | SYSTEM BUS | TIMING (Refer to | Figures 9, | 10, 11 and 12) |
|--------------|------------|------------------|------------|----------------|
|--------------|------------|------------------|------------|----------------|

| Characterisic | Symbol | Min | Тур | Max | Unit |
|--------------------------------------|-------------------|-----|-----|--------------------------|------|
| Cycle Time | t _{cyc} | 0.8 | _ | 2 0 | μS |
| System Address Setup | tSAS | 30 | _ | _ | ns |
| System Address Hold | [†] SAH | 0 | - | _ | ns |
| System Data Delay Read Semaphore | ^t SDDR | 03 | | 0 3 + t _{cyc} * | μS |
| RAM | tSDDR | | 315 | - | ns |
| System Data Valid | tSDV | 0 | | - | ns |
| System Data Hold Read | tSDHR | 30 | | 90 | ns |
| System Data Delay Write Semaphore | tSDDW | •• | _ | •• | ns |
| RAM | tSDDW | - | - | 60 | ns |
| System Data Hold Write | tSDHW | 0 | - | | ns |
| Data Acknowledge Semaphore | †DAL | 05 | _ | 05+t _{cyc} * | μS |
| RAM | †DAL | _ | 315 | _ | ns |
| Data Acknowledge High | †DAH | _ | - | 60 | ns |
| Data Acknowledge Three-State | ^t DAT | | - | 90 | ns |
| Data Acknowledge Low to CS High | tDCS | 60 | _ | | ns |

^{*}Actual value dependent upon clock period

FIGURE 9 - ASYNCHRONOUS READ OF SEMAPHORE REGISTER

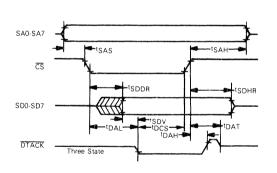


FIGURE 10 - ASYNCHRONOUS WRITE OF SEMAPHORE REGISTER

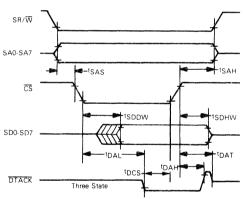


FIGURE 11 - ASYNCHRONOUS READ OF RAM

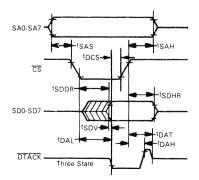
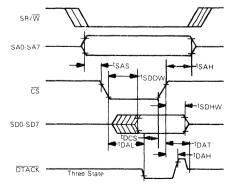


FIGURE 12 - ASYNCHRONOUS WRITE OF RAM



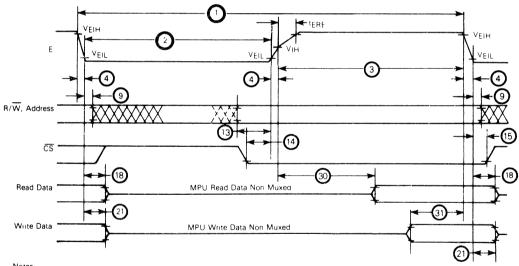
Note Timing measurements are referenced to and from a low voltage of 0.8 volts and a high voltage of 2.0 volts, unless otherwise noted

^{**}Data need not be valid on write to Semaphore Registers

| SYNCHRONOUS SYSTEM BUS TIMING (S | See Notes | 1 and 2) |
|----------------------------------|-----------|----------|
|----------------------------------|-----------|----------|

| Ident | Characteristic | Symbol | MC68120/ MC68121 | | MC68120-1 MC68121-1 | | Unit |
|--------|---------------------------------|---------------------------------|---------------------|------|------------------------|------|------|
| Number | | | Min | Max | Min | Max | |
| 1 | Cycle Time | tcyc | 10 | 10 | 0 80 | 10 | μS |
| 2 | Pulse Width, E Low | PWEL | 430 | 9500 | 360 | 9500 | ns |
| 3 | Pulse Width, E High | PWEH | 450 | 9500 | 360 | 9500 | ns |
| 4 | Clock Rise and Fall Time | t _r , t _f | - | 25 | - | 25 | ns |
| 9 | Address Hold Time | ^t AH | 10 | - | 10 | - | ns |
| 13 | Address Setup Time Before E | tAS | 80 | - | 70 | - | ns |
| 14 | Chip Select Setup Time Before E | tCS | 80 | - | 70 | - | ns |
| 15 | Chip Select Hold Time | [†] CH | 10 | - | 10 | - | ns |
| 18 | Read Data Hold Time | tDHR | 30 | 100 | 30 | 85 | ns |
| 21 | Write Data Hold Time | tDHW | 10 | - | 10 | - | ns |
| 30 | Output Data Delay Time | †DDR | - | 290 | - | 240 | ns |
| 31 | Input Data Setup Time | ^t DSW | 165 | - | 120 | - | ns |
| | Clock Enable Rise Time Extended | tere | - | 80 | - | 80 | ns |

FIGURE 13 - SYNCHRONOUS SYSTEM BUS TIMING



Notes

- $^{\circ}$ Voltage levels shown are V $_{L}\!\leq\!0$ 5 V, V $_{H}\!\geq\!2$ 4 V, unless otherwise specified 2 Measurement points shown are 0.8 V and 2.0 V, unless otherwise specified

INTRODUCTION

The MC68120/MC68121 is an 8-bit Intelligent Peripheral Controller (IPC) which can be configured to function in a wide variety of applications. This extraordinary flexibility is provided by its ability to be hardware programmed into eight different operating modes. These operating modes allow the IPC to operate on its local bus and communicate with an external system bus through the internal dual-ported RAM. The operating mode controls the configuration of 18 of the 48 pins on the IPC, the available on-chip resources, the memory map, the location (internal or external) of interrupt vectors, and the type of local bus. The configuration of the remaining 30 pins is not controlled by the operating mode

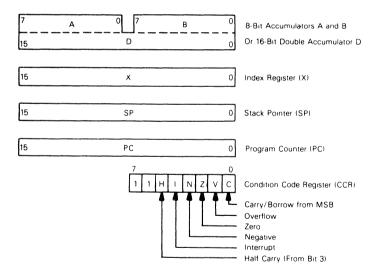
The dual-ported RAM provides a vehicle for devices on two separate buses to exchange data without directly affecting the devices on the other bus. The dual-ported RAM is accessible from the MC68120/MC68121 CPU and accessible synchronously or asynchronously to the system bus through Port 1. Semaphore registers are provided as a software tool to arbitrate shared resources such as the dual-ported RAM The semaphore registers are accessible from both buses in the same way each bus accesses the dual-ported RAM.

The remaining ports (2, 3, and 4) are I/O ports. Each port is controlled by its Data Direction Register. The CPU has direct access to the port pins of each port through its Data Register. Port pins are labeled as Pij where i identifies one of three ports and j indicates the particular bit. Port 2 is a 5-bit port which may be configured for I/O or for use of the on-chip timer and Serial Communications Interface (SCI). Ports 3 and 4 may be used as 16 bits of I/O or may form a local address and data bus with control lines allowing communications with external memory and peripherals.

The IPC contains an enhanced M6800 MPU with additional capabilities and greater throughput. It is upward source and object code compatible with the MC6800 and directly compatible with the MC6801. The programming model is depicted in Figure 14, where accumulator D is a concatenation of accumulators A and B.

The MC68121 has all of the features of the MC68120 with the exception of on-chip ROM. Thus the MC68121 normally operates in the modes utilizing external ROM (modes 2 and 3). Therefore, modes 0, 1, 4, 5, 6 and 7 should not be used.

FIGURE 14 -- PROGRAMMING MODEL



DUAL-PORTED RAM AND SEMAPHORE REGISTERS

The dual-ported RAM may be accessed from both the MC68120/MC68121 CPU and the external system bus. The six semaphore registers are tools provided for the programmer's use in arbitrating simultaneous accesses of the same resource.

For the internal CPU, the dual-ported RAM is located from \$0080 through \$00FF in all modes except 3 and 4. In mode 3,

the dual-ported RAM has been relocated in high memory from \$C080 through \$C0FF thus allowing use of direct addressing mode on external memory/peripherals. Note that no direct addressing of internal control registers is possible in mode 3. In mode 4, the internal RAM is not fully decoded and appears in locations \$XX80 through \$XXFF. From the external system bus, the dual-ported RAM is found in locations \$\frac{4}{3}\$ (10000000-111111111), as shown below in Table 1.

TABLE 1 - LOCATION OF SEMAPHORE REGISTERS AND DUAL-PORTED RAM

| System Bus Address (SA7-SA0) | Feature | IPC Address | | |
|---------------------------------|-------------------------|-------------|--|--|
| %0000 0000 - 0001 0110 | Reserved | | | |
| | Internal Registers | \$00-16 | | |
| 0001 0111 - 0001 1100 | Semaphore Registers | 17-1C | | |
| 0001 1101 - 0111 1111 | Reserved | 1D-1F | | |
| | External Mem /Unusable* | 20-7F | | |
| 1000 0000 - 1111 1111 | Dual-Ported RAM | 80-FF | | |

^{% =} Binary, \$ = Hexadecimal

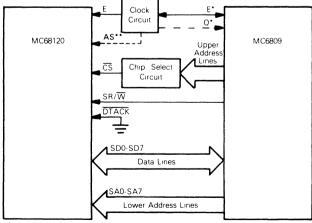
*Mode Dependent

The reserved memory areas %0-0001 0110 and %0001 1101-%0111 1111 cannot be written to from the System bus If read from the System bus these memory locations return a value of \$FF.

The dual-ported RAM is accessed from the external System bus by way of eight address lines (SAO-SA7) and eight data lines (SDO-SD7). Three control lines provide for synchronous or asynchronous access to the dual-ported RAM through Port 1. Figure 15 shows an example of a synchronous interface (using MC6809) and Figure 16 shows an example of an asynchronous interface (using MC68000). The dual-ported RAM is selected in each case by address lines SAO-SA7 and Chip Select (\overline{CS}) from the system bus. The

direction of data transfer is selected by the System Read/Write (SR/W) line. The Data Transfer Acknowledge (DTACK) signal is the asynchronous handshake required by an MC68000. Refer to DTACK under Functional Pin Description for more information. DTACK can be used to control a Memory Ready signal on the M6800 Family processor where Memory Ready capability is provided (see Figure 17). The latter would allow the M6800 Family processor to run asynchronously with the MC68120/MC68121. It should be noted that if the Memory Ready signal (on M6800 processors) is to be used with the DTACK signal, the system clock must be faster than or equal to the clock driving the IPC. Example clock circuits are shown in Figures 18 and 19

FIGURE 15 - SYNCHRONOUS SYSTEM BUS ACCESS INTERFACE



É and Q are inputs for MC6809E

Only needed in expanded multiplexed modes

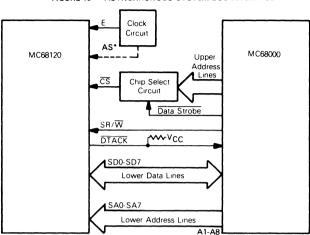


FIGURE 16 - ASYNCHRONOUS SYSTEM BUS INTERFACE

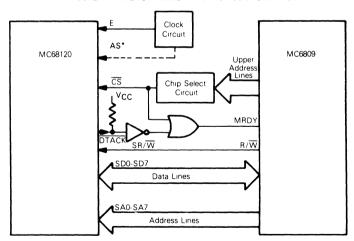


FIGURE 17 - MEMORY READY - DTACK CONFIGURATION

^{*}Only needed in expanded multiplexed modes

^{*}Only needed in expanded multiplexed modes

FIGURE 18 - CLOCK CIRCUIT EXAMPLE 1 - SCHEMATIC AND TIMING ۷cc Schematic **-** 0 U2 CLR CLR CLP CLR U1b U1a U1d U1c CLK O CLK O CLKQ CLK Q Vcc 8 MHz U1 SN74LS175 U2 SN75LS08 $t_{BC} = 10 \mu s$ Timing DΔ

The semaphore registers allow arbitration between shared resources, which may be part or all of the dual-port RAM, or a peripheral. The semaphore registers may also be used to indicate that non-reentrant code is in use or that a task is in process or is complete. To prevent the writing or reading of erroneous data from the dual-ported RAM, all simultaneous accesses involving a write to the dual-ported RAM should be avoided. The responsibility for mutual exclusion resides in software. The semaphore registers are a convenient means for the software to control the simultaneous accesses involving a write to the dual-ported RAM. Each of the six semaphore registers consist of a semaphore bit (SEM, bit 7) and an ownership bit (OWN, bit 6). The remaining six bits (b0-b5) will read all zeros.

SEMAPHORE REGISTER

| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-----|-----|---|---|---|---|---|---|
| SEM | OWN | 0 | 0 | 0 | 0 | 0 | 0 |

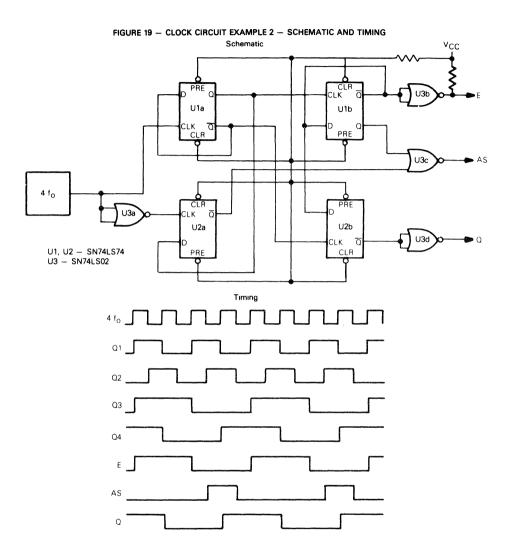
The semaphore bits are test and set bits with hardware arbitration during simultaneous accesses. Basically, the semaphore bit is cleared when written and set when read, during a single processor access. This is shown in Table 2.

TABLE 2 — SINGLE PROCESSOR SEMAPHORE BIT TRUTH TABLE

| Original SEM Bit | R/W | Data Read | Resulting SEM Bit |
|---------------------|-----|--------------|----------------------|
| 0 | R | 0• | 1 |
| 1 | R | 1* | 1 |
| 0 | W | _ | 0 |
| 1 | W | _ | 0 |

*0 - Resource Available

1 - Resource Not Available



The data written is disregarded and the information obtained from the Read may be interpreted as: 0 — resource available, 1 — resource not available. Thus, any write to a semaphore clears the semaphore bit and makes the associated resource "available".

An access where both the IPC and system processors attempt to read or write the same semaphore register simultaneously is a contested access. During a contested access, the hardware decides which processor reads a clear semaphore bit and which reads a set semaphore bit. Table 3 describes contested operation of a semaphore bit

The IPC always reads the actual semaphore bit, the system processor reads the semaphore bit in all cases except the simultaneous read of a clear semaphore bit. This arbitration during a simultaneous read ensures that only one processor reads a clear bit and therefore controls the resource that processor is arbitrarily the IPC

In Table 3, the first four states are considered proper and they occur in correctly written software. The last four states are improper and only exist in improperly written software

The ownership bit is a read-only bit that indicates which processor sets the semaphore bit if the semaphore bit is set, the ownership bit indicates which processor set it if the semaphore bit is not set, the ownership bit indicates which processor last set the semaphore bit, OWN=0, the other processor set SEM, OWN=1, this processor set SEM

The reset state of the semaphore and ownership bits is defined in Table 4. All of the semaphore bits are set after an MC68120/MC68121 reset. The IPC owns all of them except the second semaphore which is owned by the system processor. This configuration should prevent the system processor from reading a clear semaphore and implying the system processor set it when the IPC RESET is held low.

TABLE 3 - DUAL PROCESSOR SEMAPHORE BIT TRUTH TABLE

| 1 | | tem | Sys | IPC | | L | |
|-------------|----------------------|--------------|-----|--------------|-----|---------------------|--|
| | Resulting SEM Bit | Data Read | R/W | Data Read | R/W | Original SEM Bit | |
| | 1 | 1/* | R | 0* | R | 0 | |
| DDODED | 0 | _ | W | 1* | R | 1 | |
| PROPER | 0 | 1° | R | _ | W | 1 | |
| | 1 | 1. | R | 1 | R | 1 | |
| | 0 | | W | _ | W | 0 | |
| 11.400.0050 | 1 | | w | 0* | R | 0 | |
| IMPROPER | 0 | _ | w | _ | W | 1 | |
| | 1 1 | 0. | R | | W | 0 | |

^{*0 -} Resource Available

TABLE 4 - RESET STATE OF SEMAPHORE REGISTER

| SEM Reg No. | IPC | | System | |
|-------------------|-----|-----|--------|-----|
| | Sem | Own | Sem | Own |
| 1 | 1 | 1 | 1 | 0 |
| 2 | 1 | 0 | 1 | 1 |
| 3 | 1 | 1 | 1 | 0 |
| 4 | 1 | 1 | 1 | 0 |
| 5 | 1 | 1 | 1 | 0 |
| 6 | 1 | 1 | 1 | 0 |

PROGRAM STORAGE MEMORY - ROM

The standard MC68120 comes preprogrammed with a monitor in the ROM. Custom programs are placed in ROM by special order (see Appendix A).

The MC68120 contains 2048 bytes of on-chip, mask programmable read-only memory (ROM) in memory locations \$F800 through \$FFFF The contents of this ROM allows the IPC to perform a custom function for the user The interrupt vectors \$FFF0-\$FFFF are decoded to provide vectors at the top of resident ROM Address lines A12 and A13 of the

decoder for the ROM may be mask programmed as a 0 or a 1 to change the ROM starting address from \$F800 to \$C800, \$D800 or \$E800 A12 and A13 may also be "don't cares" in this decoder. Address \$FFEF is reserved for the checksum value for the ROM. This value is the complement of the "Exclusive OR" of the 2047 bytes of mask programmed ROM. An IPC without ROM is also available as the MC68121. The MC68121 should only be used in modes 2 and 3 to access external ROM after reset.

FUNCTIONAL PIN DESCRIPTIONS

VCC AND VSS

 V_{CC} and V_{SS} provide power and ground to the IPC. The power supply should provide ± 5 volts ($\pm 5\%$) to V_{CC} and V_{SS} should be tied to ground. Total power dissipation should not exceed P_D milliwatts

RESET

The reset function is used for three purposes. The first is to provide the IPC with an orderly and defined start-up procedure from a powerdown condition. The second is to return to start-up conditions without an intervening powerdown condition. The third is to provide a control signal to latch the operating mode.

During reset (low logic level on RESET pin), execution of the current instruction is suspended and the CPU enters a "reset state." The register contents are not pushed onto the stack and their contents become undefined during reset. The "reset state" initializes the IPC, as shown in Table 5.

On the positive edge of RESET, the IPC latches the operating mode from P22, P21 and P20, and then configures Port 3, Port 4, SC1 and SC2. The restart vector is then fetched and transferred to the program counter, then instruction execution begins.

Reset timing is illustrated in Figure 20 The RESET line must be held low for a minimum of three E-cycles for the IPC to complete its entire reset sequence. An external RC-network may be used to obtain the required timing

ENABLE - E

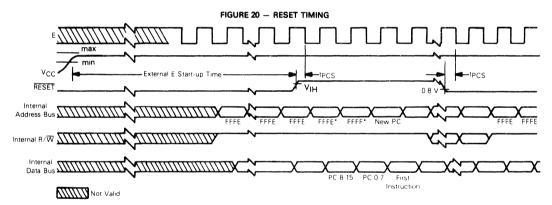
The E clock input is required for timing to synchronize Data Bus transfers A "CPU E-cycle" (or bus cycle) consists of a negative half-cycle of E followed by a positive half-cycle. For any given bus cycle, the address is valid during the negative half-cycle of E and the selected device must be enabled to the Data Bus during the next positive half-cycle. The data bus is active only while E is high. It should be noted

^{1 -} Resource Not Available

TABLE 5 - STATE OF IPC DURING RESET

| TABLE 5 - STATE OF IPC DURING RESET | | | | | | |
|--|---|--|--|--|--|--|
| Bits or Registers | Effective State | | | | | |
| CPU I-Bit | set (IRQ1 and IRQ2 disabled) | | | | | |
| NMI Interrupt Latch | cleared (NMI disabled) | | | | | |
| Halt Control Bit | cleared (HALT/BA selected) | | | | | |
| All Data Direction Registers | cleared | | | | | |
| SCI Rate and Mode Control Register | cleared | | | | | |
| Receive Data Register | cleared | | | | | |
| Timer Control and Status Register | cleared | | | | | |
| Free Running Counter | cleared | | | | | |
| Buffer for LSB of Counter | cleared | | | | | |
| Port 3 Control and Status Register | cleared | | | | | |
| Port 2, 3, 4 Data Registers | undefined after Power-up Reset, and not changed after | | | | | |
| | Reset | | | | | |
| SCI Transmit/Receive Control and Status Register | Preset to \$20 | | | | | |
| Output Compare Register | Preset to \$FFFF | | | | | |
| Semaphore Bits | Preset to 1's | | | | | |
| Ownership Bit of Semaphore Register 2 | Preset to System Ownership | | | | | |
| All other Ownership Bits | Preset to IPC Ownership | | | | | |
| All Ports 2 and 3 Lines | High Impedance (inputs) | | | | | |
| All Port 4 Lines | High Impedance (inputs) with pullup resistors | | | | | |
| SC1* | High Impedance with pullup resistors | | | | | |
| SC2 | Active High | | | | | |

^{*}If in mode 5, SC1 will go active high, otherwise it will remain in the high impedance state



^{*}Mode 0 - \$BFFE, BFFF

Note Timing measurements are referenced to and from a low voltage of 0.8 volts and a high voltage of 2.0 volts, unless otherwise noted

that this input should have some provision to obtain the specified logical high level which is greater than standard TTI levels

Enable is the primary IPC system timing signal and all timing data specified as cycles is assumed to be referenced to this clock unless otherwise noted

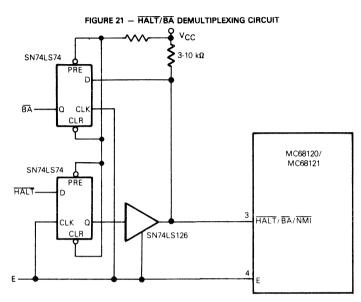
HALT/BUS AVAILABLE/NON-MASKABLE INTERRUPT — HALT/BA/NMI

The HALT/BA/NMI (pin 3) serves one of two functions. These functions are $\overline{\text{NMI}}$ or Halt/BA and the function selected is determined by the Halt Control (HC, bit 2) bit of the Functional Control Register (location \$14). If the HC bit is set (to a "1"), then the $\overline{\text{NMI}}$ function is activated. Alternately, if HC is cleared (to a "0" as it is during reset), the Halt/BA

function is activated. An external pullup resistor to V_{CC} is required on pin 3 for eitner function. Typical pullup resistor values range from 3K to 10K depending on the drive capability of the external device.

When the \$\overline{NMI}\$ function is implemented, pin 3 is configured as an input. A negative edge on pin 3 then requests an IPC non-maskable interrupt sequence, but the current instruction will be completed before responding to this request. To assure an interrupt under all conditions, \$\overline{NMI}\$ must be held low for at least one E-cycle \$\overline{NMI}\$ may be used to cause the IPC to exit the Wait instruction. For interrupt timing specifications, see the interrupt portion of the Operating Mode Section.

When configured to utilize the Halt/BA function of this pin, such as after reset, the circuit of Figure 21 is recommended to detect and supply continuous $\overline{\text{HALT}}$ and $\overline{\text{BA}}$

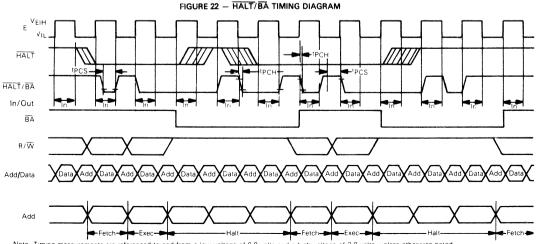


signals Figure 22 shows the appropriate timing diagram for Halt/BA with the recommended circuit. The pullup resistor shown in the circuit maintains a high logic level when HALT is not active. During a positive half-cycle of E, pin 3 is an input sampled to determine if the Halt State is requested (active low). During the negative half cycle of E, the $\overline{\rm BA}$ signal is output through pin 3. After the request for Halt State signal is detected and the processor completes its current instruction, the CPU is halted and the active low $\overline{\rm BA}$ signal is output through pin 3 during the negative half cycle of E. The local bus is then available for other devices to utilize until the Halt State signal has returned to a high level, thus allowing the

IPC back on the local bus. During the Halt State, the R/\overline{W} is high, and the address bus displays the address of the next instruction

When single instruction operation is desired, in program debug for instance, it is advantageous to single step through instructions. After \overline{BA} goes low, \overline{HALT} must be brought high for one E-cycle and returned low again to single step through instructions. Figure 22 illustrates the timing involved while single stepping through a single byte, two bus cycle instruction, such as CLRA.

BA is not output in response to the Wait instruction. If interrupts are to be utilized in removing the processor from a



Note. Timing measurements are referenced to and from a low voltage of 0.8 volts and a high voltage of 2.0 volts, unless otherwise noted

Wait State while in the Halt/BA mode then, $\overline{IRQ1}$ and $\overline{IRQ2}$ are the only interrupts which may do so; therefore, their masks must be cleared before entering the Wait State.

MASKABLE INTERRUPT REQUEST 1 - IRQ1

This level-sensitive input can be used to request an interrupt sequence. The IPC will complete the current instruction before it responds to the request. If the interrupt mask bit (I-bit) in the Condition Code Register is clear, the IPC will begin an interrupt sequence: a vector is fetched from \$FFF8 and \$FFF9, transferred to the Program Counter, and instruction execution is continued at the new location. This is explained in greater detail in the Interrupt Section.

IRQ1 typically requires an external resistor (3K to 10K depending on external devices drive capability) to V_{CC} for wire-OR applications. IRQ1 has no internal pullup resistor.

STROBE CONTROL 1 AND 2 - SC1 and SC2

The functions of SC1 and SC2 depend on the operating mode SC1 is configured as an input in all modes except the Expanded Non-Multiplexed Mode, whereas SC2 is always an output. SC1 and SC2 can drive one Schottky load and 90 pF

Single Chip Modes — In these modes, SC1 and SC2 are configured as an input and output, respectively, and both function as Port 3 control lines. SC1 functions as an input strobe (IS3) and can be used to indicate that Port 3 input data is ready or output data has been accepted. Three options associated with $\overline{\text{IS3}}$ are controlled by the Control and Status Register for Port 3 and are discussed in the Port 3 description.

SC2 is configured as an output strobe $(\overline{OS3})$ and can be used to strobe output data or acknowledge input data for Port 3. It is controlled by Output Strobe Select (OSS) in the Port 3 Control and Status Register. The strobe is generated by a read (OSS=0) or write (OSS=1) to the Port 3 Data Register. $\overline{OS3}$ timing is shown in Figure 6

Expanded Non-Multiplexed Mode — In this mode, both SC1 and SC2 are configured as outputs SC1 functions as Input/Output Select (IOS) and is asserted (active-low) only when addresses \$0100 through \$01FF are accessed. SC2 is configured as R/\overline{W} and is used to control the direction of local data bus transfers. An MPU read is enabled when R/\overline{W} and E are high.

Expanded Multiplexed Modes — In these modes, SC1 is configured as an input and SC2 is configured as an output in the expanded multiplexed modes, the IPC has the ability to access a 64K byte address space SC1 functions as an input, Address Strobe, which controls demultiplexing and enabling of the eight least significant addresses and the data buses.

By using a transparent latch such as an SN74LS373 or MC6882, Address Strobe (AS) can also be used to demultiplex the two buses external to the IPC. (See Figure 23.) SC2 provides the local Data Bus control signal called Read/Write (R/W) SC2 is configured as R/W and is used to control the direction of local data bus transfers. An MPU read is enabled when R/W and E are high

SYSTEM BUS INTERFACE

Port 1 is a mode-independent 8-bit data port which permits the external system bus to access the dual-ported RAM and semaphore registers either asynchronously or synchronously with respect to the E clock In addition to the eight data lines (SD0-SD7), eight address (SA0-SA7) and three control lines (SR/W, CS, DTACK) are used to access the dual-ported RAM and semaphore registers

Port 1 Data Lines (SD0-SD7) — These data lines are bidirectional data lines which allow data transfer between the dual-ported RAM or the semaphore registers, and the system bus. The data bus output drivers are three-state devices which remain in the high-impedance state except.

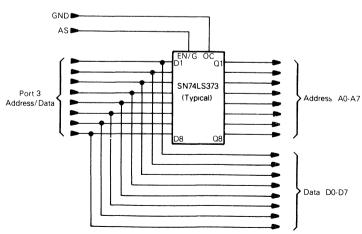


FIGURE 23 - TYPICAL LATCH ARRANGEMENT

during a read of the IPC dual-ported RAM or semaphore registers by the system processor

System Address Lines (SA0-SA7) — The address lines together with the Chip Select signal allow any of the 128 bytes of RAM or six semaphore registers to be uniquely selected from the system bus. The address lines must be valid before the \overline{CS} signal goes low for the asynchronous interface and valid before the E signal goes high for the synchronous interface. The system interface must be deselected between reads or between writes for the asynchronous operation.

System Read/Write (SR/W) — This signal is generated by the system bus to control the direction of data transfer on the data bus. With the IPC selected, a low on the SR/W line enables the input buffers, and data is transferred from the system processor to the IPC. When SR/W is high and the chip is selected, the data output buffers are turned on and data is transferred from the IPC to the system bus

Chip Select ($\overline{\text{CS}}$) — This signal is a TTL compatible input signal, used to activate the system bus interface and allows transfer of data between the IPC and the system processor during synchronous or asynchronous accesses $\overline{\text{CS}}$ provides the synchronizing signal for the Semaphore registers during access by the system bus

Data Transfer Acknowledge (DTACK) — This bidirectional control line is used to determine synchronous or asynchronous system bus accesses and to provide the data acknowledge signal for asynchronous data transfers

As an input, it is sampled on the falling edge of \overline{CS} by the IPC to determine if the system bus is being accessed synchronously or asynchronously with respect to the E clock

If \overline{DTACK} is low when sampled, the system bus is synchronous and data will be transferred during E high as shown in Figure 13.

If DTACK is high when sampled, the system bus is asynchronous. In this mode DTACK becomes an output that is asserted low when data is on the bus during a system read or when a data transfer is completed during a system write. Refer to Figures 9 through 12.

DTACK requires an external pullup resistor when the system bus is run asynchronously since it is then a bidirectional handshake line for information transfer on the system data bus

PORT 2 - P20-P24

Port 2 is a mode independent 5-bit I/O port where each line is configured by its Data Direction Register During reset, all lines are configured as inputs. The TTL compatible three-state output buffers can drive one Schottky TTL load and 30 pF, or CMOS devices using external pullup resistors P20, P21 and P22 must always be connected to provide the operating mode.

PORT 2 DATA REGISTER

7 6 5 4 3 2 1 0

PC2 PC1 PC0 P24 P23 P22 P21 P20 \$0

Inputs on P20, P21 and P22 determine the operating mode which is latched into the Program Control Register on the positive edge of RESET. The mode may be read from the Port 2 Data Register (PC2 is latched from pin 45)

Port 2 also provides an interface for the Serial Communications Interface and Timer. Bit 1, if configured as an output, is dedicated to the Timer Output Compare function and cannot be used to provide output from the Port 2 Data Register.

PORT 3 - P30-P37

Port 3 can be configured as an I/O port, a bi-directional 8-bit data bus, or a multiplexed address/data bus depending upon the operating mode. The TTL compatible three-state output buffers can drive one Schottky TTL load and 90 pF

Single Chip Modes — In these modes, Port 3 is an 8-bit I/O port where each line is configured by the Port 3 Data Direction Register Associated with Port 3 are two lines, IS3 and OS3, which can be used to control Port 3 data transfers

Three Port 3 options, controlled by the Port 3 Control and Status Register and available only in the Single Chip Modes are 1) Port 3 input data can be latched using $\overline{1S3}$ as a control signal, 2) $\overline{OS3}$ can be generated by either an IPC read or write to the Port 3 Data Register, and 3) an $\overline{IRQ1}$ interrupt can be enabled by an $\overline{IS3}$ negative edge. Port 3 latch timing is shown in Figure 7

PORT 3 CONTROL AND STATUS REGISTER

| | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | |
|---|------|--------|---|-----|--------|---|---|---|------|
| | | IS3 | Х | oss | LATCH | Х | Х | X | \$0F |
| ı | FLAG | IRQ1 | | | ENABLE | | 1 | | 1 |
| ı | | ENABLE | | | | | l | 1 | |

Bits 0-2 Not used.

- Bit 3 LATCH ENABLE This bit controls the input latch for Port 3. If set, input data is latched by an IS3 negative edge. The latch is transparent after a read of the Port 3. Data Register. LATCH ENABLE is cleared by Reset
- Bit 4 OSS (Output Strobe Select) This bit determines whether OS3 will be generated by a read or write of the Port 3 Data Register When clear, the strobe is generated by a read, when set, it is generated by a write OSS is cleared by Reset
- Bit 5 Not used.
- Bit 6 IS3-IRQ1 ENABLE When set, an IRQ1 interrupt will be enabled whenever IS3 FLAG is set, when clear, the interrupt is inhibited. This bit is cleared by Reset
- Bit 7 IS3 FLAG This read-only status bit is set by an IS3 negative edge. It is cleared by a read of the Port 3 Control and Status Register (with IS3 FLAG set) followed by a read or write to the Port 3 Data Register or by Reset.

Expanded Non-Multiplexed Mode — In this mode, Port 3 is configured as a bi-directional data bus (D0-D7). The direction of data transfers is controlled by R/\overline{W} (SC2). Data transfers are clocked by E (Enable)

Expanded Multiplexed Modes — In these modes, Port 3 is configured as a time-multiplexed address (AO-A7) and data bus (DO-D7). Address Strobe (AS) must be input on SC1, and can be used externally to de-multiplex the two buses. Port 3 is held in a high-impedance state between valid address and data to prevent potential bus conflicts.

PORT 4 -- P40-P47

Port 4 is configured as 8-bit I/O port, as address outputs, or as data inputs depending on the operating mode. Port 4 can drive one Schottky TTL load and 90 pF and is the only port with internal pullup resistors.

Single Chip Modes — In these modes, Port 4 functions as an 8-bit I/O port where each line is configured by the Port 4 Data Direction Register. Internal pullup resistors allow the port to directly interface with CMOS at 5 volt levels. External

pullup resistors to more than 5 volts, however, cannot be used.

Expanded Non-Multiplexed Mode — In this mode, Port 4 is configured from reset as an 8-bit input port, where the Data Direction Register can be written, to provide any or all of address lines A0-A7. Internal pullup resistors are intended to pull the lines high until the Data Direction Register is configured.

Expanded Multiplexed Mode — In all these modes except Mode 6, Port 4 functions as half of the address bus and provides A8 to A15. In Mode 6, the port is configured from reset as an 8-bit parallel input port, the Port 4 Data-Direction Register must be written to provide any or all of address lines, A8 to A15. Internal pullup resistors are intended to pull the lines high until the Data Direction Register is configured (bit 0 controls A8, etc.).

OPERATING MODES

The IPC provides eight different operating modes which are selectable by hardware programming and referred to as Modes 0 through 7. The operating mode controls the memory map, configuration of Port 3, Port 4, SC1 and SC2 and the address location of the interrupt vectors

FUNDAMENTAL MODES

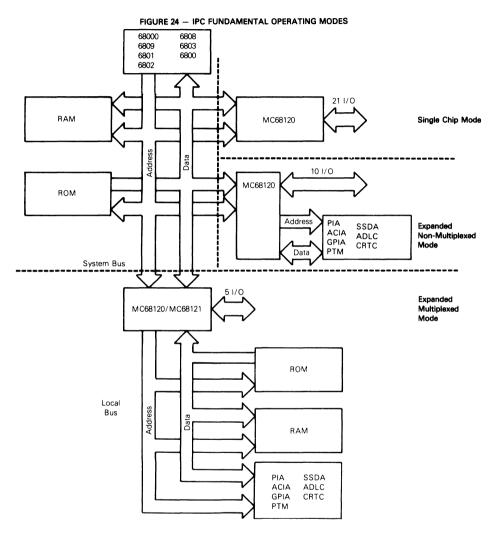
The eight modes of the IPC can be grouped into three fundamental modes which refer to the type of bus it supports Single Chip, Expanded Non-Multiplexed, and Expanded Multiplexed Single Chip includes Modes 4 and 7, Expanded Non-Multiplexed is Mode 5 and the remaining five are Expanded Multiplexed modes A system utilizing three MC68120's, one in each of the fundamental operating modes, is shown in Figure 24 Table 6 summarizes the characteristics of the operating modes

Single Chip Modes (4, 7) — In Single Chip Mode, three of the four IPC ports are configured as parallel input/output data ports, as shown in Figure 25. The IPC functions as a complete microcomputer in these two modes without external address or data buses. A maximum of 21 I/O lines and two Port 3 control lines are provided

In Single Chip Test Mode (4), the RAM responds to addresses \$XX80 (X = don't care) through \$XXFF and the ROM is removed from the internal address map. A test program must first be loaded into the RAM using Modes 0, 1, 2, or 6 If the IPC is reset and then programmed into Mode 4, execution will begin at \$XXFE XXFF. Mode 5 can be irreversibly entered from Mode 4 without going through reset by setting bit 5 of the Port 2 Data Register. This mode is used primarily to test Port 3 and 4 in the Single Chip and Non-Multiplexed Modes.

| TARIFE | - SUMMAR | Y OF IPC C | DEFRATING MOD | FS |
|--------|----------|------------|---------------|----|

| TABLE 0 = SOMMANT OF IFC OPERATING MODES | | | | | | |
|--|---|--|--|--|--|--|
| Common to all Modes System Bus Interface Reserved Register Area 6 Semaphore Registers I/O Port 2 Programmable Timer Serial Communications Interface 128 bytes of Dual Ported RAM | Expanded Multiplexed Modes Four Memory Space Options (64K Address Space) (1) MDOS Compatible (2) No ROM (3) External Vector Space (4) ROM with Partial Address Bus* External Memory Space Accessed Through Port 3 as a Multiplexed Address/Data Bus | | | | | |
| Single Chip Mode* 2048 Bytes of ROM (Internal) Port 3 is a Parallel I/O Port with Two Control Lines Port 4 is a Parallel I/O Port | Port 4 as an Address Bus (High) SC1 is Address Strobe Bus (AS) Input SC2 is Read/Write ($\mathbb{R}/\overline{\mathbb{W}}$) | | | | | |
| SC1 is Input Strobe 3 (IS3) SC2 is Output Strobe 3 (OS3) | Test Modes Expanded Multiplexed Test Mode | | | | | |
| Expanded Non-Multiplexed Mode* 2048 Bytes of ROM (Internal) 256 Bytes of External Memory Space Port 3 is an 8-Bit Data Bus Port 4 is an Address Bus | May be Used to Test RAM and ROM* Single Chip and Non-Multiplexed Test Mode* May be Used to Test Ports 3 and 4 as I/O Ports | | | | | |
| SC1 is Input/Output Select (IOS) SC2 is Read/Write (R/W) | *MC68120 only | | | | | |



Expanded Non-Multiplexed Mode (5) — A modest amount of external memory space is provided in the Expanded Non-Multiplexed Mode while retaining significant on-chip resources Port 3 functions as an 8-bit bi-directional data bus and Port 4 is configured as an input data port. Any combination of A0 to A7 may be provided while retaining the remainder as input data lines. Any combination of the eight least-significant address lines may be obtained by writing to the Port 4 Data Direction Register. Internal pullup resistors are provided to pull Port 4 lines high until it is configured.

Figure 26 illustrates the external resources available in the Expanded Non-Multiplexed Mode. The IPC interfaces directly with M6800 Family parts and can access 256 bytes of external address space at \$100 through \$1FF IOS provides an address decode of external memory (\$100-\$1FF) and may be used as an address or chip select line

Expanded-Multiplexed Modes (0, 1, 2, 3, 6) — In the Expanded Multiplexed Modes, the IPC has the ability to access a 64K-byte memory space Port 3 functions as a time-multiplexed address/data bus with address valid on the negative edge of Address Strobe (AS) and the data bus valid while E is high. In Modes 0 to 3, Port 4 provides address lines A8-A15. However, in Mode 6, Port 4 can provide any subset of A8 to A15 while retaining the remainder as input lines Writing 1's to the desired bits in the Data Direction Register (DDR) will output the corresponding address lines while the remaining bits will remain inputs (as configured from reset or from 0's written to the DDR). Internal pullup resistors are provided to pull Port 4 lines high until software configures the port. Initialization of Port 4 in Mode six must be done to obtain any upper address lines externally.

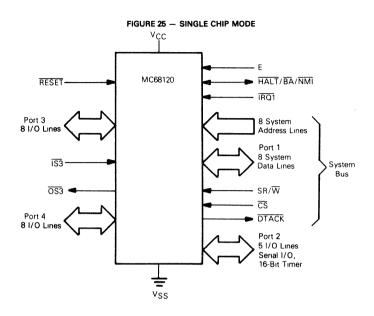


FIGURE 26 - EXPANDED NON-MULTIPLEXED MODE

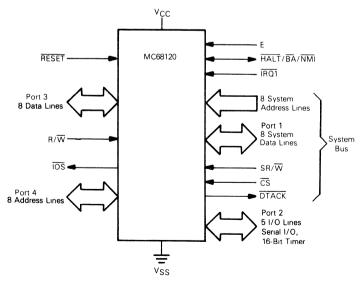
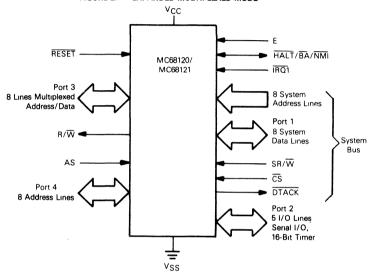


Figure 27 depicts the external resources available in the Expanded-Multiplexed Modes. Address Strobe can be used to control a transparent D-type latch to capture addresses AO-A7, as shown in Figure 23. This allows Port 3 to function as a Data Bus when E is high.

In Mode 0, the reset vector is external at \$BFFE and \$BFFF

after the positive edge of RESET. In addition, the internal and external data buses are connected together so there must be no memory map overlap (to avoid potential bus conflicts). Mode 0 is used primarily to verify the ROM pattern and monitor the internal data bus with automated test equipment.

FIGURE 27 - EXPANDED MULTIPLEXED MODE



MODE PROGRAMMING

The operating mode is programmed by the levels asserted on P22, P21, and P20 during the positive edge of $\overline{\text{RESET}}$ These are latched into PC2, PC1, and PC0 of the program control register. The operating mode may be read from the Port 2 Data Register and programming levels and timing must be met as shown in Figure 28 and Table 7 A brief outline of the operating modes is shown in Table 8

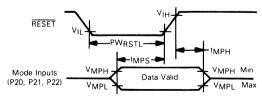
Circuitry to provide the programming levels is primarily dependent on the normal system use of the three pins. If configured as outputs, the circuit shown in Figure 29 may be

used, otherwise, the three-state buffers can be used to provide isolation while programming the mode

MEMORY MAPS

The IPC provides up to 64K bytes of address space depending upon the operating mode. A memory map for each operating mode is shown in Figure 30. In Modes 1R and 6R, the "R" means the ROM has been relocated by a mask option. The first 32 locations of each map are reserved for the IPC internal register area, as shown in Table 9, with exceptions as indicated.

FIGURE 28 - MODE PROGRAMMING TIMING



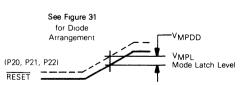


TABLE 7 - MODE PROGRAMMING SPECIFICATIONS (See Figure 30)

| Characteristic | Symbol | Min | Тур | Max | Unit |
|--|------------------|-----|-----|-----|----------|
| Mode Programming Input Voltage Low | VMPL | _ | _ | 18 | ٧ |
| Mode Programming Input Voltage High | VMPH | 40 | _ | _ | V |
| Mode Programming Diode Differential (if Diodes are Used) | VMPDD | 0.6 | _ | _ | V |
| RESET Low Pulse Width | PWRSTL | 30 | - | _ | E-Cycles |
| Mode Programming Setup Time | tMPS | 20 | - | | E-Cycles |
| Mode Programming Hold Time | | | | | |
| RESET Rise Time≥1 µs | [†] MPH | 0 | - | - | ns |
| RESET Rise Time < 1 µs | | 100 | - | | |

TABLE 8 - MODE SELECTION SUMMARY

| Mode | Pin 45 P22 PC2 | Pin 44 P21 PC1 | Pin 43 P20 PC0 | ROM | RAM | interrupt Vectors | Bus Mode | Operating Mode |
|------|----------------------|----------------------|----------------------|------|------------------|----------------------|------------------------|---|
| 7 | Н | Н | Н | 1 | 1 | 1 | ı | Single Chip |
| 6 | Н | Н | L | - | ı | ı | MUX ^(5, 6) | Multiplexed/Partial Decode ⁽⁵⁾ |
| 5 | н | L | Н | ı | 1 | ı | NMUX ^(5, 6) | Non-Multiplexed/Partial Decode ⁽⁵⁾ |
| 4 | Н | L | L | l(2) | l(1) | ı | ı | Single Chip Test |
| 3 | L | Н | Н | E | ₁ (7) | E | MUX ⁽⁴⁾ | Multiplexed/RAM ⁽⁴⁾ |
| 2 | L | н | L | E | 1 | E | MUX ⁽⁴⁾ | Multiplexed/RAM ⁽⁴⁾ |
| 1 | L | L | Н | 1 | 1 | E | MUX ⁽⁴⁾ | Multiplexed/RAM and ROM(4) |
| 0 | L | L | L | 1 | I | E(3) | MUX ⁽⁴⁾ | Multiplexed Test ⁽⁴⁾ |

Legend:

I - Internal

E — External

MUX — Multiplexed NMUX — Non-Multiplexed

1 ---- "0"

L - Logic "0"

H - Logic "1"

Notes.

- (1) Internal RAM is addressed at \$XX80
- (2) Internal ROM is disabled
- (3) Interrupt vectors externally located at \$BFF0-\$BFFF
- (4) Addresses associated with Ports 3 and 4 are considered external in Modes 0, 1, 2, and 3
- (5) Addresses associated with Port 3 are considered external in Modes 5 and 6
- (6) Port 4 default is user data input, address output is optional by writing to Port 4 Data Direction Register
- (7) Internal RAM and registers located at \$C0XX (for use with MDOS)

FIGURE 29 - TYPICAL MODE PROGRAMMING CIRCUIT

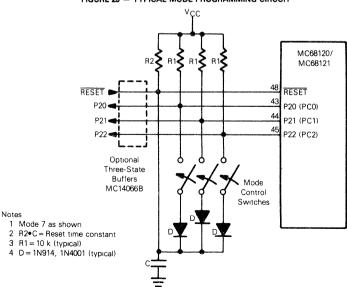
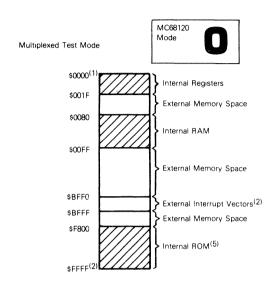


FIGURE 30 - IPC MEMORY MAPS

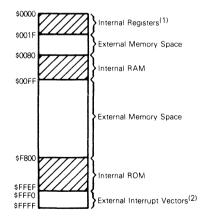


Notes

- Excludes the following addresses which may be used externally \$04, \$05, \$06, \$07 and \$0F
- The interrupt vectors are externally located at \$BFF0-\$BFFF
- There must be no overlapping of internal and external memory spaces to avoid driving the data bus with more than one device
- This mode is the only mode which may be used to examine the interrupt vectors in internal ROM using an external RESET vector
- 5) MC68120 only



Multiplexed/RAM and ROM

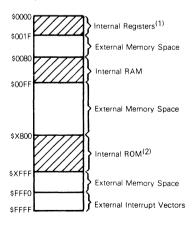


Notes

- Excludes the following addresses which may be used externally \$04, \$05, \$06, \$07 and \$0F
- Internal ROM addresses \$FFF0 to \$FFFF are not usable



Multiplexed/RAM and ROM

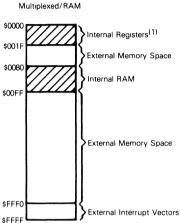


Notes

- Excludes the following addresses which may be used externally \$04, \$05, \$06, \$07, and \$0F
- Starting addresses for the internal ROM may be \$C800, \$D800 or \$E800 as a mask option

FIGURE 30 - IPC MEMORY MAPS (CONTINUED)

MC68120/ MC68121 Mode



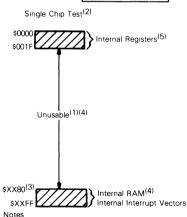
Notes

 Excludes the following addresses which may be used externally \$04, \$05, \$06, \$07, and \$0F MC68120/ MC68121 Mode

Notes

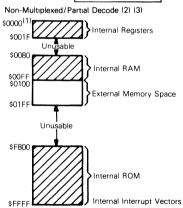
- Relocating the internal registers and the internal RAM to high memory allows processor to run MDOS
- Excludes the following addresses which may be used externally \$C004, \$C005, \$C006, \$C007, and \$C00F

MC68120 Mode



- 1) The internal ROM is disabled
- Mode 4 may be changed to Mode 5 without having to assert RESET by writing a "1" into bit 5 (PCO) of Port 2 Data Register
- Addresses A8 to A15 are treated as "don't cares" to decode internal RAM
- 4) Internal RAM will appear at \$XX80 to \$XXFF
- MPU Read of Port 3 Data Direction Register will access Port 3 Data Register instead

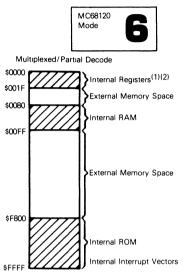
MC68120 Mode



Notes

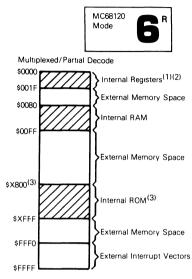
- 1) Excludes the following addresses which may not be used externally \$04, \$06, and \$0F (no IOS)
- This mode may be entered without going through Reset by using Mode 4 and subsequently writing a "1" into bit 5 (PCO) of Port 2 Data Register
- 3) Address lines A0 to A7 will not contain addresses until the Data Direction Register for Port 4 has been written with "1's" in the appropriate bits These address lines will assert "1's" until made outputs by writing the Data Direction Register

FIGURE 30 - IPC MEMORY MAPS (CONCLUDED)



Notes

- Excludes the following addresses which may be used externally \$04, \$06, \$0F
- 2) Address lines A8-A15 will not contain addresses until the Data Direction Register for Port 4 has been written with "1's" in the appropriate bits These address lines will assert "1's" until made outputs by writing the Data Direction Register



Notes

- Excludes the following addresses which may be used externally \$04, \$06, \$0F
- 2) Address lines A8-A15 will not contain addresses until the Data Direction Register for Port 4 has been written with "1's" in the appropriate bits These address lines will assert "1's" until made outputs by writing the Data Direction Register
- 3) Starting addresses for the internal ROM may be \$C800, \$D800 or \$E800



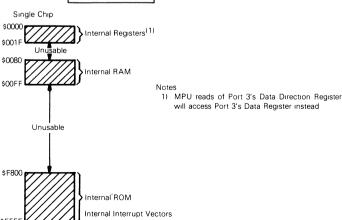


TABLE 9 - INTERNAL REGISTER AREA

| Register | Address**** (Hexadecimal) | Register | Address**** (Hexadecimal) |
|-------------------------------------|------------------------------|--|------------------------------|
| Reserved | 00 | SCI Rate and Mode Control Register | 10 |
| Port 2 Data Direction Register*** | 01 | Transmit/Receive Control and Status Register | 11 |
| Reserved | 02 | SCI Receive Data Register | 12 |
| Port 2 Data Register | 03 | SCI Transmit Data Register | 13 |
| Port 3 Data Direction Register*** | 04* | | 1 |
| Port 4 Data Direction Register*** | 05** | Function Control Register | 14 |
| Port 3 Data Register | 06* | Counter Alternate Address (High Byte) | 15 |
| Port 4 Data Register | 07** | Counter Alternate Address (Low Byte) | 16 |
| Timer Control and Status Register | 08 | Semaphore 1 | 17 |
| Counter (High Byte) | 09 | Semaphore 2 | 18 |
| Counter (Low Byte) | 0A | Semaphore 3 | 19 |
| Output Compare Register (High Byte) | OB | Semaphore 4 | 1A |
| Output Compare Register (Low Byte) | 0C | Semaphore 5 | 1B |
| Input Capture Register (High Byte) | 0D | Semaphore 6 | 1C |
| Input Capture Register (Low Byte) | 0E | Reserved | 1D-1F |
| Port 3 Control and Status Register | OF* | | |

^{*}These external addresses in Modes 0, 1, 2, 3, 5, 6 cannot be accessed in Mode 5 (no $\overline{|OS}$)

INTERRUPTS

The IPC supports two types of interrupt requests Maskable and Non-Maskable. A Non-Maskable Interrupt (NMI) is always recognized and acted upon at the completion of the current instruction. Maskable interrupts are controlled by the Condition Code Register I-bit and by individual enable bits. The I-bit controls all maskable interrupts Of the maskable interrupts, there are two types. $\overline{IRQ1}$ and $\overline{IRQ2}$. The Programmable \overline{Iimer} and Serial Communications interface use an internal $\overline{IRQ2}$ interrupt line, as shown in the block diagram of the IPC. External devices (and $\overline{ISQ3}$) use $\overline{IRQ1}$ an $\overline{IRQ1}$ interrupt is serviced before an $\overline{IRQ2}$ interrupt if both are pending

All IRQ2 interrupts use hardware prioritized vectors. The

single SCI interrupt and three timer interrupts are serviced in a prioritized order where each is vectored to a separate location. All IPC vector locations are shown in Table 10, from highest (top) to lowest (bottom) priority.

The interrupt flowchart is depicted in Figure 31. The Program Counter, Index Register, Accumulator A, Accumulator B, and Condition Code Register are pushed to the stack. The l-bit is set to inhibit maskable interrupts and a vector is fetched corresponding to the current highest priority interrupt. The vector is transferred to the Program Counter and instruction execution is resumed. The general interrupt timing sequence is shown in Figure 32. The Interrupt HALT/BA timing is illustrated in Figure 21 and 22.

TABLE 10 - MCU VECTOR LOCATIONS*

| MSB | LSB | Interrupt |
|--------|------|--------------------------|
| \$FFFE | FFFF | RESET** |
| FFFC | FFFD | NMI |
| FFFA | FFFB | Software Interrupt (SWI) |
| FFF8 | FFF9 | IRQ1 (or IS3) |
| FFF6 | FFF7 | ICF (Input Capture) |
| FFF4 | FFF5 | OCF (Output Compare) |
| FFF2 | FFF3 | TOF (Timer Overflow) |
| FFF0 | FFF1 | SCI (RDRF + ORFE + TDRE) |

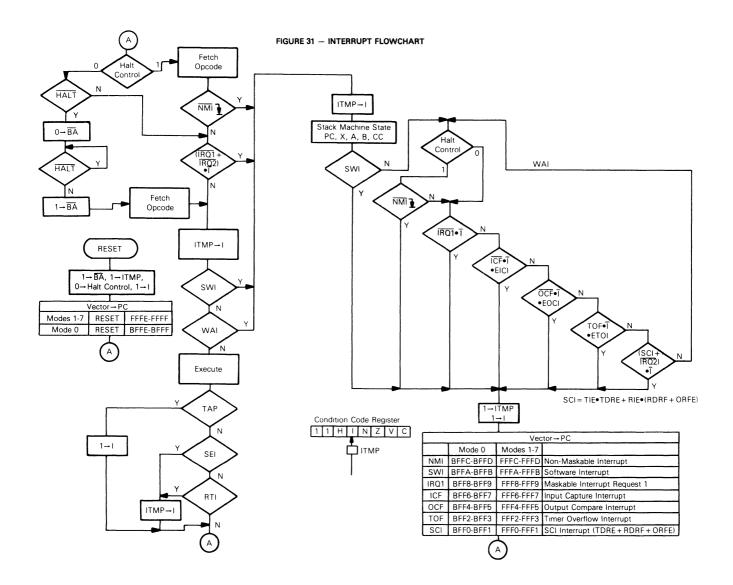
^{*}These locations are relocated at \$BFF0-\$BFFF in Mode 0

^{**}These are external addresses in Modes 0, 1, 2, 3

^{***1 =} Output, 0 = Input

^{****}These addresses relocated at \$C000-\$C01F in Mode 3

^{**}Highest priority



Data Bus

Internal R/W

FIGURE 32 - INTERRUPT SEQUENCE Last Instruction-Ε I-Bit Set Internal Address Bus On Code On Code MSB Addr LSB Addr Address Addr Addr + 1IRO1 ters NMI or IRO2 -tpcs First Inst of Interrupt Routine Internal

PROGRAMMABLE TIMER

The Programmable Timer can be used to perform input waveform measurements while independently generating an output waveform. Pulse widths can vary from several microseconds to many seconds. A block diagram of the Timer is shown in Figure 33.

Op Code Op Code

TIMER CONTROL AND STATUS REGISTER (\$08)

The Timer Control and Status Register (TCSR) is an 8-bit register of which all bits are readable while bits 0-4 can be written. The three most significant bits provide the timer status and they indicate:

- a proper level transition has been detected, or
- a match has been found between the free-running counter and the output compare register, or
- the free-running counter has overflowed.

Each of the three events can generate an $\overline{\text{IRQ2}}$ interrupt and is controlled by an individual enable bit in the TCSR

TIMER CONTROL AND STATUS REGISTER
(TSCR)

Bit 0 OLVL Output level. OLVL is clocked to the output level register by a successful output compare and will appear at P21 if Bit 1 of the Port 2 Data Direction Register is set. It is cleared by reset

Bit 1 IEDG Input Edge. IEDG is cleared by reset and controls which level transition will trigger a counter transfer to the Input Capture Register.

IEDG = 0 Transfer on a negative edge

IEDG = 1 Transfer on a positive edge

Bit 2 ETOI Enable Timer Overflow Interrupt When set, an IRO2 interrupt is enabled for a timer overflow;

when clear, the interrupt is inhibited. It is cleared by reset.

Irrelevant Data

Bit 3 EOCI Enable Output Compare Interrupt When set, an IRQ2 interrupt is enabled for an output compare, when clear, the interrupt is inhibited. It is cleared by reset.

Bit 4 EICI Enable Input Capture Interrupt. When set, an IRO2 interrupt is enabled for an input capture, when clear, the interrupt is inhibited. It is cleared by reset

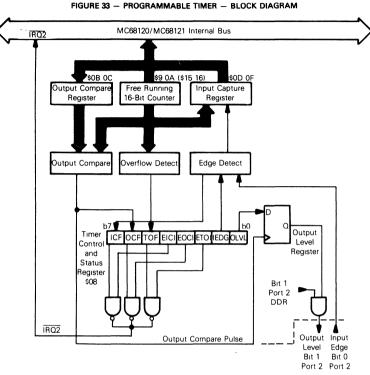
Bit 5 TOF Timer Overflow Flag. TOF is set when the counter contains all 1's. It is cleared by reading the TCSR (with TOF set) followed by reading the highest byte of the counter (\$09), or by reset Reading the counter at \$15 will not clear TOF

Bit 6 OCF Output Compare Flag OCF is set when the Output Compare Register matches the free-running counter It is cleared by reading the TCSR (with OCF set) and then writing to the Output Compare Register (\$0B or \$0C), or by reset.

Bit 7 ICF Input Capture Flag ICF is set to indicate a proper level transition. It is cleared by reading the TCSR (with ICF set) and then reading the Input Capture Register High Byte (90D), or by reset.

COUNTER (\$09:0A)

The key timer element is a 16-bit free-running counter which is incremented by E (Enable). It is cleared during reset and is a read-only with one exception: a write to the counter (\$09) will preset it to \$FFF8. This feature, intended for testing, can disturb serial operations because the counter provides the SCI internal bit rate clock. TOF is set whenever the counter contains all 1's. The counter may also be read at location \$15 and \$16 to avoid the clearing of the TOF.



OUTPUT COMPARE REGISTER (\$0B:0C)

The Output Compare Register is a 16-bit Read/Write register used to control an output waveform or provide an arbitrary timeout flag It is compared with the free-running counter on each E-cycle. When a match is found, OCF is set and OLVL is clocked to an output level register. If Port 2, bit 1 is configured as an output, OLVL will appear at P21. The Output Compare Register and OLVL can then be changed for the next compare. The compare function is inhibited for one cycle after a write to the high byte of the counter (\$0B) to ensure a valid compare The Output Compare Register is set to \$FFFF by reset

INPUT CAPTURE REGISTER (\$0D:0E)

The Input Capture Register is a 16-bit read-only register used to store the free-running counter when a "proper" input transition occurs as defined by IEDG Port 2, bit 0 should be configured as an input, but the edge detect circuit always senses P20, even when configured as an output. An input capture can occur independently of ICF the input capture register always contains the most current value regardless of whether ICF was previously set or not Counter transfer is inhibited, however, between accesses of a double byte IPC read. The input pulse width must be at least two E-cycles to ensure an input capture under all conditions.

SERIAL COMMUNICATIONS INTERFACE (SCI)

A full-duplex asynchronous Serial Communications Interface (SCI) is provided with two data formats and a choice of Baud rates The SCI transmitter and receiver are functionally independent, but use the same data format and bit rate Serial data formats include standard mark/space (NRZ) and Bi-phase. Both formats provide one start bit, eight data bits, and one stop bit. "Baud" and "bit rate" are used synonymously in the following description

WAKE-UP FEATURE

In a typical serial loop multi-processor configuration, the software protocol will usually identify the addressee(s) at the

beginning of the message. In order to allow uninterested MPUs to ignore the remainder of the message, a wake-up feature is included whereby all further SCI receiver flag (and interrupt) processing can be inhibited until the data line goes idle. An SCI receiver is re-enabled by an idle string of ten consecutive 1's or by reset Software must provide the required idle string between consecutive messages and prevent it within messages.

PROGRAMMABLE OPTIONS

The following features of the SCI are programmable:

• format: standard mark/space (NRZ) or Bi-phase

- clock: external or internal clock source
- Baud rate: one of four per E-clock frequency, or oneeighth of the external clock input to P22
- wake-up features: enabled or disabled
- interrupt requests: enabled individually for transmitter and receiver
- clock output: internal bit rate clock enabled or disabled to P22

SERIAL COMMUNICATIONS REGISTERS

The Serial Communications Interface includes four addressable registers as depicted in Figure 34. It is controlled by the Rate and Mode Control Register and the Transmit/Receive Control and Status Register. Data is transmitted and received utilizing a write-only Transmit Register and read-only Receive Register. The shift registers are not accessible by software.

Rate and Mode Control Register (\$10) — The Rate and Mode Control Register (RMCR) controls the SCI Baud rate, format, clock source, and under certain conditions, the configuration of P22. The register consists of four write-only bits which are cleared by reset. The two least significant bits control the Baud rate of the internal clock and the remaining two bits control the format and clock source.

RATE AND MODE CONTROL REGISTER (RMCR)

| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | |
|---|---|---|---|-----|-----|-----|-----|------|
| Х | Х | Х | Х | CC1 | CCO | SS1 | SS0 | \$10 |

- Bit 1: Bit 0 SS1.SS0 Speed Select. These two bits select the Baud rate when using the internal clock Four rates may be selected which are a function of the IPC input frequency (E). Table 11 lists bit times and rates for three selected IPC frequencies
- Bit 3: Bit 2 CC1.CC0 Clock Control and Format Select These two bits control the format and select the senal clock source. If CC1 is set, the Data Direction Register (DDR) value for P22 is forced to the complement of CC0 and cannot be altered until CC1 is cleared. If CC1 is cleared after having been set, its DDR value is unchanged Table 12 defines the format, clock source, and use of P22

If both CC1 and CC0 are set, an external TTL compatible clock must be connected to P22 at eight times (8X) the desired Baud rate, but not greater than E, with a duty cycle of 50% (\pm 10%). If CC1.CC0=10, the internal Baud rate clock is provided at P22 regardless of the values for TE or RE

NOTE: The source of SCI internal baud rate clock is the free-running counter of the timer. An IPC write to the counter can disturb serial operations.

FIGURE 34 - SCI REGISTERS

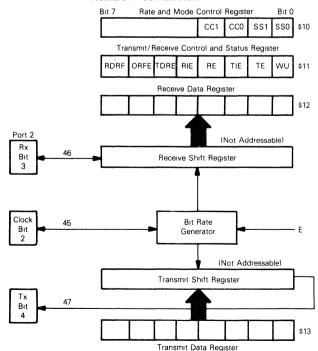


TABLE 11 - SCI BIT TIMES AND RATES

| SS1:SS0 | E | 614.4 kHz | 1.0 MHz | 1.2288 MHz |
|---------|--------|-------------------|---------------------|---------------------|
| 0 0 | + 16 | 26 µs/38,400 Baud | 16 μs/62,500 Baud | 13 0 μs/76,800 Baud |
| 0 1 | + 128 | 208 μs/4,800 Baud | 128 μs/7812 5 Baud | 104 2 μs/9,600 Baud |
| 1 0 | + 1024 | 1 67 ms/600 Baud | 1 024 ms/976,6 Baud | 833 3 µs/1,200 Baud |
| 1 1 | + 4096 | 6 67ms/150 Baud | 4 096 ms/244 1 Baud | 3 33 ms/300 Baud |

Bit 6 ORFE

TABLE 12 - SCI FORMAT AND CLOCK SOURCE CONTROL

| CC1:CC0 | Format | Clock Source | Port 2 Bit 2 |
|---------|----------|-----------------|-----------------|
| 0 0 | Bı-Phase | Internal | Not Used |
| 0 1 | NRZ | Internal | Not Used |
| 1 0 | NRZ | Internal | Output |
| 1 1 | NRZ | External | Input |

Transmit/Receive Control and Status Register (\$11) — The Transmit/Receive Control and Status Register (TRCSR) controls the transmitter, receiver, wake-up features, and two individual interrupts and monitors the status of serial operations. All eight bits are readable while only bits 0 to 4 are writable. The register is initialized to \$20 by reset.

TRANSMIT/RECEIVE CONTROL AND STATUS REGISTER (TRCSR)

| 7 | 6 | 5 | 4 | 3 | 2 | 1_ | 0 | |
|------|------|------|-----|----|-----|----|----|------|
| RDRF | ORFE | TDRE | RIE | RE | TIE | TE | WU | \$11 |

Bit 0 WU "Wake-up" on Idle Line. When set, WU enables the wake-up function, it is cleared by ten consecutive 1's or by reset WU will not set if the line is idle.

Bit 1 TE

Transmit Enable. When set, the P24 DDR bit is set, cannot be changed, and will remain set if TE is subsequently cleared. When TE is changed from clear to set, the transmitter is connected to P24 and a preamble of nine consecutive 1's is transmitted. TE is cleared by reset.

Bit 2 TIE Transmit Interrupt Enable When set, an IRQ2 interrupt is enabled when TDRE is set, when clear, the interrupt is inhibited. TIE is cleared by reset.

Bit 3 RE Receive Enable. When set, the P23 DDR bit is cleared, cannot be changed, and will remain clear if RE is subsequently cleared. While RE is set, the SCI receiver is enabled. RE is cleared by reset

Bit 4 RIE

Receiver Interrupt Enable. When set, an IRQ2
interrupt is enabled when RDRF and/or ORFE
is set; when clear, the interrupt is inhibited.
RIE is cleared by reset.

Bit 5 TDRE Transmit Data Register Empty TDRE is set when the contents of the Transmit Data Register is transferred to the output serial shift register or by reset. It is cleared by reading the TRCSR (with TDRE set) and then writing to the Transmit Data Register Additional data

will be transmitted only if TDRE has been cleared.

Overrun Framing Error. If set, ORFE indicates either an overrun or framing error. An overrun occurs when a new byte is ready to transfer to the Receiver Data Register with RDRF still set. A receiver framing error has occurred when the byte boundaries of the bit stream are not synchronized to the bit counter. An overrun can be distinguished from a framing error by the value of RDRF: if RDRF is set, then an overrun has occurred, otherwise, a framing error has been detected. Data is not transferred to the Receive Data Register in an overrun condition. ORFE is cleared by reading the RCSR (with ORFE set) then reading the Receive Data Register, or by reset.

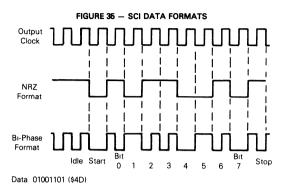
Bit 7 RDRF Receive Data Register Full. RDRF is set when the contents of the input serial shift register is transferred to the Receive Data Register. It is cleared by reading the TRCSR (with RDRF set), and then reading the Receive Data Register, or by reset.

SERIAL OPERATIONS

The SCI is initialized by writing the control bytes first to the Rate and Mode Control Register and then to the Transmit/Receive Control and Status Register. When TE is set, the output of the Transmit Shift Register is connected to P24 and serial output is initiated by the transmission of a 9-bit preamble of 1's.

At this point one of two situations exist: 1) if the Transmit Data Register is empty (TDRE=1), a continuous string of 1's will be sent indicating an idle line, or 2) if a byte has been written to the Transmit Data Register (TDRE=0), the byte will be transferred to the Transmit Shift Register (synchronized with the bit rate clock), TDRE will be set, and transmission will begin.

The start bit (0), eight data bits (beginning with bit 0) and a stop bit (1), will be transmitted. If TDRE is still set when the next byte transfer should occur, 1's will be sent until more data is provided. Receive operation is controlled by RE which configures P23 as an input and enables the receiver. In Biphase format, the output toggles at the start of each bit and at half time when a "1" is sent. SCI data formats are illustrated in Figure 35. In receiving Bi-phase, a "1" is input when two transitions occur in less than 3/4 bit-time, and a "0" is input when more than 3/4 bit-time passes after a transition on P23.



INSTRUCTION SET

The MC68120/MC68121 is upward source and object code compatible with the MC6800 processor and directly compatible with the M6801 Family processors.

PROGRAMMING MODEL

A programming model for the MC68120/MC68121 is shown in Figure 14. Accumulator A can be concatenated with accumulator B and jointly referred to as accumulator D where A is the most significant byte. Any operation which modifies the double accumulator will also modify accumulator A and/or B. Other registers are defined as follows:

Program Counter — The program counter is a 16-bit register which always points to the next instruction.

Stack Pointer — The Stack Pointer is a 16-bit register which contains the address of the next available location in a pushdown/pullup (LIFO) queue. The stack resides in random access memory at a location specified by the software.

Index Register — The Index Register is a 16-bit register which can be used to store data or provide an address for the indexed mode of addressing

Accumulators — The IPC contains two 8-bit accumulators, A and B, which are used to store operands and results from the arithmetic logic unit (ALU). They can also be concatenated and referred to as the D (double) accumulator.

Condition Code Register — The Condition Code Register indicates the results of an instruction and includes the following five condition bits: Negative (N), Zero (Z), Overflow (V), Carry/Borrow from MSB (C), and half carry from bit 3 (H). These bits are testable by the conditional branch instructions Bit 4 is the interrupt mask (I-bit) and inhibits all maskable interrupts when set. The two unused bits b6 and b7, are read as ones.

ADDRESSING MODES

The MC68120/MC68121 provides six addressing modes which can be used to reference memory. A summary of addressing modes for all instructions is presented in Tables 13, 14, 15 and 16 where execution times are provided in

E-cycles Instruction execution times are summarized in Table 17. With an input frequency (E) of 1 MHz, E-cycles are equivalent to microseconds. A cycle-by-cycle description of bus activity for each instruction is provided in Table 18 and a description of selected instructions is shown in Figure 38.

Immediate Addressing — The operand is contained in the following byte(s) of the instruction where the number of bytes matches the size of the register. These are two or three byte instructions.

Direct Addressing — The least significant byte of the operand address is contained in the second byte of the instruction and the most significant byte is assumed to be \$00. Direct addressing allows the user to access \$00 through \$FF using two byte instructions and execution time is reduced by eliminating the additional memory access (refer to Table 1) In most applications, this 256-byte area is reserved for frequently referenced data. Note that no direct addressing of internal control registers is possible in Mode 3

Extended Addressing — The second and third bytes of the instruction contain the absolute address of the operand. These are three byte instructions

Indexed Addressing — The unsigned offset contained in the second byte of the instructions is added with carry to the Index Register and used to reference memory without changing the Index Register These are two byte instructions.

Inherent Addressing — The operand(s) are registers and no memory reference is required. These are single byte instructions

Relative Addressing — Relative addressing is used only for branch instructions. If the branch condition is true, the Program Counter is overwritten with the sum of a signed single byte displacement in the second byte of the instruction and the current Program Counter. This provides a branch range of -126 to 129 bytes from the first byte of the instruction These are two byte instructions.

TABLE 13 - INDEX REGISTER AND STACK MANIPULATION INSTRUCTIONS

| | | | | | | | | Г | | | | _ | | | | | | T | Con | diti | on (| Cod | es |
|------------------------|----------|----|----------|----|----------|-----|-----|----|-----|---|----|-----|----|-----|-----|-----|--|---|-----|----------|------|-----|-----------|
| | | In | nm | ed | D | ire | ct | li | nde | X | E | xtı | ١d | Ini | ner | ent | t | 5 | 4 | 3 | 2 | 1 | 0 |
| Pointer Operations | Mnemonic | OP | ~ | # | OP | ~ | # | OP | ~ | # | OP | ~ | # | OP | ~ | # | Boolean ∕ | Н | T | N | Z | V | С |
| | | | L | L | | L | L | | L | Ш | L | L | L | | L | L | Arithmetic Operation | 丄 | L | <u> </u> | | | L |
| Compare Index Reg | CPX | 8C | 4 | 3 | 9C | 5 | 2 | AC | 6 | 2 | ВС | 6 | 3 | | ١ | | X - M M + 1 | • | • | I | 1 | 1 | М |
| Decrement Index Reg | DEX | | Г | | | | | | | | | | | 09 | 3 | 1 | X - 1 - - X | • | • | • | 1 | • | • |
| Decrement Stack Pntr | DES | | Γ | | | | | | | | | | | 34 | 3 | 1 | SP - 1 SP | • | • | • | • | • | • |
| Increment Index Reg | INX | | Γ | Г | | Г | | | | | Г | Γ | | 08 | 3 | 1 | X + 1X | • | • | • | 1 | • | • |
| Increment Stack Pntr | INS | | Г | Г | | Г | Г | | Г | | | Г | | 31 | 3 | 1 | 1 SP + 1 SP | • | • | • | • | • | • |
| Load Index Reg | LDX | CE | 3 | 3 | DE | 4 | 2 | EE | 5 | 2 | FE | 5 | 3 | | | | MX _H , (M + 1)X _L | • | • | T | 1 | R | • |
| Load Stack Pntr | LDS | 8E | 3 | 3 | 9E | 4 | 2 | ΑE | 5 | 2 | BE | 5 | 3 | | | | M -SPH, (M + 1) -SPL | • | • | 1 | 1 | R | • |
| Store Index Reg | STX | | Г | | DF | 4 | 2 | EF | 5 | 2 | FF | 5 | 3 | | | Г | X _H M, X _L (M + 1) | • | • | П | 1 | R | • |
| Store Stack Pntr | STS | | | | 9F | 4 | 2 | AF | 5 | 2 | BF | 5 | 3 | | | | SPH M, SPL (M + 1) | • | • | П | 1 | R | • |
| Index Reg → Stack Pntr | TXS | | | Γ | | | Г | | | | | Γ | | 35 | 3 | 1 | X - 1 - SP | • | • | • | • | • | • |
| Stack Pntr → Index Reg | TSX | | | | | | | | | | | Г | | 30 | 3 | 1 | SP + 1X | • | • | • | • | • | • |
| Add | ABX | | Г | Ι | | | | | | | | | | 3A | 3 | 1 | B + XX | • | • | • | • | • | • |
| Push Data | PSHX | | Г | Г | Г | Г | Г | | | | Г | T | | 3C | 4 | 1 | XL -MSP, SP - 1 -SP | • | | • | • | • | |
| | | L | L | L | | | L | | L | | | L | | | | | XH -MSP SP - 1 -SP | | L | | | | |
| Pull Data | PULX | | Γ | | Ι | | l - | | | | | Γ | | 38 | 5 | 1 | SP + 1 -SP, MSP -XH | • | • | • | • | • | • |
| | | | <u> </u> | | <u>L</u> | | L | | | | | L | | | | l | SP + 1 -SP, MSP -XL | _ | L | | | | |

TABLE 14 - ACCUMULATOR AND MEMORY INSTRUCTIONS

| Accumulator and | | In | nme | d | D | ire | ct | 1 | nde | ĸ | E | kter | ١d | - | nhe | r | Boolean | C | on | ditie | on (| Cod | es |
|-------------------|------|-----------|-----|---|----|----------|----------|----|-----|----------|----|------|----------|----|----------|---|-----------------------|---|----|--------|----------|-----|--------|
| Memory Operations | MNE | Op | ~ | # | Op | ~ | # | Op | ~ | # | Op | ~ | # | Op | ~ | # | Expression | Н | T | N | Z | V | C |
| Add Acmitrs | ABA | | | | | | | | | | | | | 18 | 2 | 1 | A + B - A | П | | H | \prod | П | П |
| Add B to X | ABX | | | | | | | | | | | | | ЗА | 3 | 1 | 00 B + X - X | • | • | • | | | |
| Add with Carry | ADCA | 89 | 2 | 2 | 99 | 3 | 2 | Α9 | 4 | 2 | B9 | 4 | 3 | | | | A + M + C - A | | • | П | \Box | П | T |
| | ADCB | C9 | 2 | 2 | D9 | 3 | 2 | E9 | 4 | 2 | F9 | 4 | 3 | | | | B + M + C - B | 1 | • | П | \prod | Π | T |
| Add | ADDA | 8B | 2 | 2 | 9B | 3 | 2 | ΑB | 4 | 2 | ВВ | 4 | 3 | | | | A + M A | H | • | It | П | T | T |
| | ADDB | СВ | 2 | 2 | DB | 3 | 2 | EB | 4 | 2 | FB | 4 | 3 | | | | B + M → A | П | • | П | 1 | 1 | 1 |
| Add Double | ADDD | C3 | 4 | 3 | D3 | 5 | 2 | E3 | 6 | 2 | F3 | 6 | 3 | | | | D + M M + 1 - D | • | • | П | | | |
| And | ANDA | 84 | 2 | 2 | 94 | 3 | 2 | Α4 | 4 | 2 | B4 | 4 | 3 | | | П | A·M -A | • | • | T | \Box | R | • |
| | ANDB | C4 | 2 | 2 | D4 | 3 | 2 | E4 | 4 | 2 | F4 | 4 | 3 | | | П | B · M → B | • | • | | | R | • |
| Shift Left, | ASL | | | | | Г | | 68 | 6 | 2 | 78 | 6 | 3 | | | | | • | • | | | T | 1 |
| Arithmetic | ASLA | | | | | | | | | | | | | 48 | 2 | 1 | | • | • | 1 | \Box | 1 | \Box |
| | ASLB | | | | | | | | | | | | | 58 | 2 | 1 | | • | • | | | | |
| Shift Left Dbl | ASLD | | | | | | | | | | | | | 05 | 3 | 1 | | • | • | II | \Box | | |
| Shift Right, | ASR | | | | | | | 67 | 6 | 2 | 77 | 6 | 3 | | | | | • | • | 1 | | 1 | |
| Arithmetic | ASRA | | | | | | | | | | | | | 47 | 2 | 1 | | • | • | 1 | | 1 | |
| | ASRB | | | | | | | | | | | | | 57 | 2 | 1 | | • | • | T | | | T |
| Bit Test | BITA | 85 | 2 | 2 | 95 | 3 | | Α5 | 4 | 2 | В5 | 4 | 3 | | | Г | A · M | • | • | | | R | • |
| | BITB | C5 | 2 | 2 | D5 | 3 | 2 | E5 | 4 | 2 | F5 | 4 | 3 | | | | B · M | • | • | 1 | 1 | R | • |
| Compare Acmitrs | CBA | | | | | | | | | | | | | 11 | 2 | 1 | A - B | • | • | 1 | T | 1 | 11 |
| Clear | CLR | | | | | | | 6F | 6 | 2 | 7F | 6 | 3 | | | | 00 - M | • | • | R | s | Ŕ | R |
| | CLRA | | | | | | | | | | | | | 4F | 2 | 1 | 00 - A | • | • | R | s | R | R |
| | CLRB | | | | | | | | | | | | | 5F | 2 | 1 | 00 - B | • | • | R | s | R | R |
| Compare | CMPA | 81 | 2 | 2 | 91 | 3 | 2 | A1 | 4 | 2 | B1 | 4 | 3 | | | | A - M | • | • | 1 | T | 1 | 1 |
| | CMPB | C1 | 2 | 2 | D1 | 3 | 2 | E1 | 4 | 2 | F1 | 4 | 3 | | | | B - M | • | • | \Box | | 1 | \Box |
| 1's Complement | сом | | | | | | | 63 | 6 | 2 | 73 | 6 | 3 | | | | M→M | • | • | П | | Ŕ | s |
| | COMA | | | | | | | | | | | | | 43 | 2 | 1 | A A | • | • | П | | R | s |
| | сомв | | | | | | | | | | | | | 53 | 2 | 1 | B→B | • | • | 1 | | R | s |
| Decimal Adj, A | DAA | - | П | | | | | | | _ | _ | | \Box | 19 | 2 | 1 | Adj binary sum to BCD | • | • | 1 | \sqcap | 1 | T |
| Decrement | DEC | | Н | | Ι | \vdash | \vdash | 6A | 6 | 2 | 7A | 6 | 3 | | | H | M - 1 M | • | • | H | 1 | H | • |
| ******** | DECA | <u> </u> | | | | | | | | \vdash | | - | | 4A | 2 | 1 | A - 1 - A | • | • | H | 11 | H | • |
| | DECB | | 1 | Н | _ | | Н | | _ | | | _ | \vdash | 5A | | | | • | • | Ħ | H | H | • |
| Exclusive OR | EORA | 88 | 2 | 2 | 98 | 3 | 2 | A8 | 4 | 2 | B8 | 4 | 3 | | <u> </u> | Ė | A ⊕ M → A | ě | • | 11 | H | R | ÷ |
| | EORB | C8 | | | D8 | | | E8 | | | F8 | 4 | 3 | | \vdash | Н | B ⊕ M → B | • | • | H | 1 | R | 1 |

- Continued -

TABLE 14 — ACCUMULATOR AND MEMORY INSTRUCTIONS (CONTINUED)

| Accumulator and | T | In | nme | be | D | irec | t | Ir | ndex | | E | ten | d | li | nhe | r | Boolean | TC | one | litic | n C | ode | |
|-------------------|-------|--|--|--|--|--|----------|--|--|----------|--|--|----------|--|--|----------|---|----|-----|-------|-----|--------|--------------|
| Memory Operations | MNE | Op | ⊺ ~ | # | Op | ~ | # | Op | ~ | # | Op | ~ | # | Oρ | ~ | # | Expression | н | T | N | Z | V | Tc |
| Increment | INC | | ╁ | - | - | _ | - | 6C | | | 7Ċ | | 3 | | _ | | M + 1 → M | • | • | 1 | Ī | Ť | • |
| moromore | INCA | t | t | \vdash | _ | _ | \vdash | - | Ť | F | | - | Ť | 4C | 2 | 1 | A + 1 A | • | • | 1 | 11 | H | • |
| | INCB | † | t | 1 | \vdash | _ | | _ | | Н | | - | | 5C | | 1 | B + 1 → B | • | • | 1 | 11 | | • |
| Load Acmitrs | LDAA | 86 | 2 | 2 | 96 | 3 | 2 | A6 | 4 | 2 | В6 | 4 | 3 | | | | M -A | | • | 1 | 11 | Ŕ | |
| Loud / tollitie | LDAB | C6 | 2 | | D6 | 3 | 2 | E6 | 4 | 2 | F6 | 4 | 3 | | _ | | M -► B | • | • | H | H | R | • |
| Load Double | LDD | CC | 3 | | DC | 4 | 2 | EC | 5 | 2 | FC | 5 | 3 | | | T | M M + 1 D | | • | 1 | 11 | R | • |
| Logical Shift, | LSL | 1 | Ť | Ť | | H | Ħ | 68 | | 2 | 78 | 6 | 3 | | | T | | • | • | 1 | Ħ | 1 | Ť |
| Left | LSLA | t — | T | | | | Т | | | | \vdash | | \vdash | 48 | 2 | 1 | | | • | 1 | 11 | 1 | \mathbf{H} |
| | LSLB | | | | | Т | П | | | П | | | _ | 58 | 2 | 1 | | • | • | 11 | 1 | 1 | Ħ |
| | LSLD | † | | 1 | | | | | | | | | | 05 | 3 | 1 | | • | • | | 1 | 1 | 11 |
| Shift Right, | LSR | T | | 1 | | | | 64 | 6 | 2 | 74 | 6 | 3 | | | | | | • | R | | 1 | 11 |
| Logical | LSRA | \vdash | | \vdash | | _ | т | _ | _ | \vdash | | | - | 44 | 2 | 1 | | • | • | R | 11 | 11 | 11 |
| _03,000 | LSRB | T | T | | | | | | | | T | T | \vdash | 54 | 2 | 1 | *************************************** | • | • | R | 1 | \Box | \Box |
| | LSRD | 1 | 一 | | | | | | \vdash | П | | 1 | | 04 | 3 | 1 | | • | | R | | | 1 |
| Multiply | MUL | † | | | | | Т | | _ | М | | 1 | | 3D | 10 | 1 | A X B - D | • | • | • | • | • | \Box |
| 2's Complement | NEG | † | T | ┢ | | l | Н | 60 | 6 | 2 | 70 | 6 | 3 | | | H | 00 - M → M | | • | 1 | 1 | 1 | + |
| (Negate) | NEGA | | | | | \vdash | | | | | | 1 | ┪ | 40 | 2 | 1 | 00 - A - A | | | 1 | 11 | 1 | Ħ |
| (rroguto) | NEGB | 1 | ┢ | 1 | | | | | | Н | <u> </u> | t^- | ┪ | 50 | 2 | 1 | 00 - BB | • | • | 1 | 1 | H | Ħ |
| No Operation | NOP | t | \vdash | 1 | | \vdash | | / | _ | ~ | | T | _ | 01 | 2 | 1 | PC + 1 PC | | • | | • | • | • |
| Inclusive OR | ORAA | 8A | 2 | 2 | 9A | 3 | 2 | AA | 4 | 2 | ВА | 4 | 3 | - | F | H | A + M A | • | | Ť | Ť | Ŕ | • |
| melasive on | ORAB | CA | 2 | | DA | 3 | 2 | EA | 4 | 2 | FA | 4 | 3 | _ | \vdash | \vdash | B + M B | | | H | 11 | R | • |
| Push Data | PSHA | T | ┢ | Ħ | | Ť | - | | Ė | 7 | | | Ť | 36 | 3 | 1 | A → Stack | | 0 | | | | |
| . doi: Data | PSHB | <u> </u> | <u> </u> | T | | | | | _ | | \vdash | T | | 37 | 3 | 1 | B - Stack | | | | | • | • |
| Pull Data | PULA | † | | t^{-} | | | Н | | | | _ | † | _ | 32 | 4 | 1 | Stack -A | | | | | | |
| | PULB | † | T | | | ┢ | М | | | | t | T | T | 33 | 4 | 1 | Stack -B | • | | | | • | |
| Rotate Left | ROL | | T | | | \vdash | | 69 | 6 | 2 | 79 | 6 | 3 | | | Т | | | | 1 | 1 | 1 | 1: |
| Hotato Lon | ROLA | | <u> </u> | t^- | | _ | Н | | Ė | Ē | | Ť | Ė | 49 | 2 | 1 | | | | H | 1 | H | 1: |
| | ROLB | 1 | | T | | | | _ | | \vdash | _ | t | T | 59 | 2 | 1 | | | | Ħ | 11 | 1 | +: |
| Rotate Right | ROR | 1 | T | 1 | | _ | | 66 | 6 | 2 | 76 | 6 | 3 | | _ | T | *************************************** | | | 11 | 11 | H | 1 |
| Tiotato Tingini | RORA | † | T | _ | | | Г | | | | | | | 46 | 2 | 1 | | | | 1 | 11 | Ť | 11 |
| | RORB | † | T | | | | _ | _ | _ | \vdash | | | \vdash | 56 | 2 | 1 | | • | • | Ħ | 11 | 1 | †† |
| Subtract Acmitr | SBA | \vdash | T | 1 | | _ | | | | | | 1 | Т | 10 | | 1 | A - B A | • | • | H | 1 | Н | \mathbf{H} |
| Subtract with | SBCA | 82 | 2 | 2 | 92 | 3 | 2 | A2 | 4 | 2 | B2 | 4 | 3 | | Ė | + | A - M - C A | • | • | 1 | 11 | 1 | +; |
| Carry | SBCB | C2 | | | D2 | | 2 | E2 | | 2 | F2 | | 3 | | | | B - M - C -B | • | • | 1 | 11 | Н | 11 |
| Store Acmitrs | STAA | 1 | F | F | 97 | 3 | 2 | A7 | 4 | 2 | B7 | 4 | 3 | \vdash | | Ħ | A -M | • | • | H | 11 | Ŕ | 1 |
| Otore Admitio | STAB | t | 1 | \vdash | D7 | 3 | 2 | E7 | 4 | 2 | F7 | 4 | 3 | | \vdash | T | B → M | | | H | 11 | R | |
| | STD | \vdash | t^- | | DD | 4 | 2 | ED | 5 | 2 | FD | 5 | 3 | | | T | D - M M + 1 | • | • | Ħ | Ħ | R | 9 |
| Subtract | SUBA | 80 | 2 | 2 | 90 | 3 | 2 | AO | _ | 2 | во | - | 3 | | _ | T | A - M A | • | • | H | 11 | 1 | Ť |
| O GD C. GOL | SUBB | co | 2 | 2 | DO | 3 | 2 | EO | 4 | 2 | FO | 4 | 3 | | \vdash | t | B - M → B | • | • | †† | ti | H | †† |
| Subtract Double | SUBD | 83 | 4 | 3 | | 5 | 2 | A3 | | 2 | В3 | <u> </u> | 3 | | _ | t | D - M M + 1 - D | • | • | 11 | 11 | H | +† |
| Transfer Acmitr | TAB | 100 | Ť | ۲ | - | <u> </u> | ┝ | - | Ť | += | 1 | Ť | Ť | 16 | 2 | 1 | A B | | | T i | ti | Ŕ | 6 |
| manater Admin | TBA | 1 | +- | +- | - | - | - | | 1 | \vdash | \vdash | t | 1 | 17 | 2 | Ιi | B - A | • | • | H | ++ | R | |
| Test, Zero or | TST | | \vdash | +- | | | \vdash | 6D | 6 | 2 | 7D | 6 | 3 | H | Ē | Ė | M - 00 | | • | 11 | H | R | |
| Minus | TSTA | 1 | t | \vdash | <u> </u> | _ | \vdash | - | Ť | 1 | <u> </u> | Ť | tŤ | 4D | 2 | 1 | A - 00 | • | • | 11 | 11 | R | |
| IVIIIIUS | TSTB | + | \vdash | \vdash | | | \vdash | | \vdash | \vdash | | +- | H | 5D | 2 | 1 | B - 00 | - | • | H | H | R | |
| | 11318 | | L | | | L | | L | L | ட | L | | _ | تت | L | Ľ | 15 50 | | | _' | | ۳, | ٠, |

The Condition Code Register notes are listed after table 16

TABLE 15 - JUMP AND BRANCH INSTRUCTIONS

| | | | | C | ond | I. C | od | e R | eg | | | | | | | | | | | | | | |
|--------------------------|----------|----|-------------|----|-----|------|-----|----------|-----|---|----|-----|----|----|------|---------------|---------------------------|---|---|---|---|---|---|
| | | | Dire | ct | R | elat | ive | <u> </u> | nde | × | E | xtn | ıd | ln | here | nt | | 5 | 4 | 3 | 2 | 1 | 0 |
| Operations | Mnemonic | OP | ' ~ | # | OF | ~ | # | OP | ~ | # | OΡ | ~ | # | OP | ~ | # | Branch Test | H | T | N | Z | V | С |
| Branch Always | BRA | Г | T | Т | 20 | 3 | 2 | | | | | | | Γ | Т | Г | None | • | • | • | • | • | • |
| Branch Never | BRN | | T | Г | 21 | 3 | 2 | П | | | | T | Г | | Τ | Γ | None | • | • | • | • | • | • |
| Branch If Carry Clear | BCC | Г | T | T | 24 | 3 | 2 | | | | | Π | Γ | | 1 | Г | C = 0 | • | • | • | • | • | • |
| Branch If Carry Set | BCS | Г | Γ | Г | 25 | 3 | 2 | | | | | Γ | | | Т | Г | C = 1 | • | • | • | • | • | • |
| Branch If = Zero | BEQ | Г | T | | 27 | 3 | 2 | | Γ | | | | Γ | | | Г | Z = 1 | • | • | • | • | • | • |
| Branch If ≥ Zero | BGE | | T | Τ | 2C | 3 | 2 | | Г | | | Γ | | Γ | T | Γ | N⊕V = 0 | • | • | • | • | • | • |
| Branch If > Zero | BGT | | Т | Г | 2E | 3 | 2 | | Г | | | Г | | | Г | | Z + (N ⊕ V) = 0 | • | • | • | • | • | • |
| Branch If Higher | BHI | | Г | Г | 22 | 3 | 2 | | | | | Г | Г | | Т | | C + Z = 0 | • | • | • | • | • | • |
| Branch If Higher or Same | BHS | | T | | 24 | 3 | 2 | | | | | | Г | Π | | Γ | C = 0 | • | • | • | • | • | • |
| Branch If ≤ Zero | BLE | | | | 2F | 3 | 2 | | | | | | | | | | Z + (N⊕V) = 1 | • | • | • | • | • | • |
| Branch If Carry Set | BLO | | Г | Г | 25 | 3 | 2 | | | | | Г | | Γ | Г | | C = 1 | • | • | • | • | • | • |
| Branch If Lower Or Same | BLS | | Γ | | 23 | 3 | 2 | | | | | | Г | | П | | C + Z = 1 | • | • | • | • | • | • |
| Branch If < Zero | BLT | | | | 2D | 3 | 2 | | | | | | | | Γ | Г | N⊕V = 1 | • | • | • | • | • | • |
| Branch If Minus | BMI | | T | | 2B | 3 | 2 | | | | | | Γ | | | П | N = 1 | • | • | • | | | • |
| Branch If Not Equal Zero | BNE | | | | 26 | 3 | 2 | | | | | | | Γ | | П | Z = 0 | • | • | • | • | • | • |
| Branch If Overflow Clear | BVC | | Г | Γ | 28 | 3 | 2 | | | | | | | | | П | V = 0 | • | • | • | • | | • |
| Branch If Overflow Set | BVS | | | | 29 | 3 | 2 | | | | | | | | | П | V = 1 | • | • | • | • | • | • |
| Branch If Plus | BPL | | Γ | Π | 2A | 3 | 2 | | | | | | | | | П | N = 0 | • | • | • | • | • | • |
| Branch To Subroutine | BSR | | | | 8D | 6 | 2 | | | | | | | | Π | П |) See Special | • | • | • | • | • | • |
| Jump | JMP | | Т | | | | Г | 6E | 3 | 2 | 7E | 3 | 3 | | Π | П | Operations — | • | • | | • | | • |
| Jump To Subroutine | JSR | 9D | 5 | 2 | | T | Г | ΑD | 6 | 2 | BD | 6 | 3 | | | П | Figure 38 | • | • | • | • | • | • |
| No Operation | NOP | | Г | T | | Τ | Γ | | | | | | | 01 | 2 | 1 | | • | • | • | • | • | • |
| Return From Interrupt | RTI | | | Г | | | Γ | | | | | | | 3B | 10 | 1 | \ | 1 | 1 | ł | I | 1 | 1 |
| Return From Subroutine | RTS | | T | Г | | Г | Τ | | П | П | | Г | | 39 | 5 | 1 | See Special | • | • | • | • | • | • |
| Software Interrupt | SWI | | Г | Π | | Π | | | | | | Г | Г | 3F | 12 | 1 | Operations — Figure 38 | • | s | • | • | • | • |
| Wait For Interrupt | WAI | | T | Г | | Τ | Γ | | | | | | Г | 3E | 9 | 9 1 Pigure 38 | • | • | • | • | • | • | |

TABLE 16 — CONDITION CODE REGISTER MANIPULATION INSTRUCTIONS

| | | | | | | C | one | 1 0 | ode | Re | g |
|----------------------|----------|----|---|---|-------------------|----|-----|-----|-----|----|---|
| | Inhere | nt | | | | 5 | 4 | 3 | 2 | 1 | 0 |
| Operations | Mnemonic | OP | ~ | # | Boolean Operation | Н | ı | N | z | V | С |
| Clear Carry | CLC | ОС | 2 | 1 | 0 - C | • | • | | • | • | R |
| Clear Interrupt Mask | CLI | 0E | 2 | 1 | 0 -1 | • | R | • | • | • | • |
| Clear Overflow | CLV | 0A | 2 | 1 | 0 - V | • | • | • | • | R | • |
| Set Carry | SEC | OD | 2 | 1 | 1 - C | • | • | • | • | • | s |
| Set Interrupt Mask | SEI | OF | 2 | 1 | 1 -1 | • | s | • | | • | • |
| Set Overflow | SEV | ОВ | 2 | 1 | 1 - V | • | • | • | • | s | • |
| Accumulator A - CCR | TAP | 06 | 2 | 1 | A - CCR | 11 | T | T | T | T | T |
| CCR -Accumulator A | TPA | 07 | 2 | 1 | CCR - A | • | • | • | • | • | • |

LEGEND

- OPOperation Code (Hexadecimal)
- ~ Number of MPU Cycles
- MSP Contents of memory location pointed to by Stack Pointer
 - # Number of Program Bytes
 - + Arithmetic Plus
 - Arithmetic Minus
- Boolean AND
- X Arithmetic Multiply
- + Boolean Inclusive OR
- ⊕ Boolean Exclusive OR
- $\overline{\mathbf{M}}$ Complement of M
- Transfer Into
- O Bit = Zero OO Byte = Zero

CONDITION CODE SYMBOLS

- H Half-carry from bit 3
- I Interrupt mask
- N Negative (sign bit) Z Zero (byte)
- V Overflow, 2's complement
- C Carry/Borrow from MSB
- Reset Always
- S Set Always
- Affected
 Not Affected

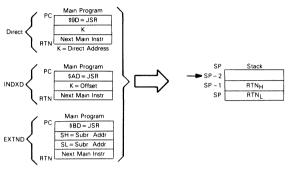
TABLE 17 - INSTRUCTION EXECUTION TIMES IN E-CYCLES

| | ADDRESSING MODE | | | | | | | | | | | | |
|--|---|-----------------------|---|----------------------------|---------------------------------|---|--|--|--|--|--|--|--|
| | | ADD | PRESSI | NG MOI | DE | | | | | | | | |
| | Immediate | Direct | Extended | Indexed | Inherent | Relative | | | | | | | |
| ABA ABX ADC ADD ADDD AND ASL | 2 2 4 2 | • • 3 3 5 3 • | • 4 4 6 4 6 | • 4 4 6 4 6 | 2 3 • • • • 2 | • | | | | | | | |
| ASLD ASR BCC BCS BEQ BGE BGT | • | • | 6 | 6 | 3 2 | • | | | | | | | |
| BHI BHS BIT BLE BLO BLS BLT | 2 • | 3 | 4 | 4 | • • • • • • | 3 3 3 3 3 3 3 3 3 3 3 3 3 3 3 3 3 3 3 | | | | | | | |
| BMI BNE BPL BRA BRN BSR BVC | • | • | • | • • • • • | • • • • • | 3 3 3 3 3 6 3 | | | | | | | |
| BVS CBA CLC CLI CLR CLV CMP | • | • | 6 | • • • 6 • 4 | • 2 2 2 2 2 • | 3 | | | | | | | |
| COM CPX DAA DEC DES DEX EOR INC | 2 4 • • • • • • • • • • • • • • • • • • | 3 5 • • • | 6 6 6 4 6 | 6 6 6 4 6 6 | 2 2 2 2 3 3 • | • | | | | | | | |

| | | ADD | RESSIN | IG MO | DE | |
|---|---------------------------------------|----------------------------|----------------------------|-----------------------|---|----------|
| | Immediate | Direct | Extended | Indexed | Inherent | Relative |
| INX JMP JSR LDA LDD LDS LDX LSL LSLD LSR LSRD MUL NEG | 2 3 3 3 3 | 5 3 4 4 4 0 | 3 6 4 5 5 5 6 6 6 6 6 | 3 6 4 5 5 5 6 6 6 6 6 | 3 • • • • 2 3 2 3 10 2 | |
| NOP ORA PSH PSHX PUL PULX ROL ROR RTI RTS SBA SBC | 2 | 3 | 4 • • • • • 6 6 6 | 6 6 6 | 2 2 3 4 4 5 2 2 10 5 2 2 | • |
| SEC SEI SEV STA STD STS STX SUB SUBD SWI | • • • • • • • • • • • • • • • • • • • | 3 4 4 4 3 5 6 | 4 5 5 5 4 6 | 4 5 5 4 6 | 2 • • • | • |
| TAB TAP TBA TPA TST TSX TXS WAI | • | • | 6 | 6 | 12 2 2 2 2 2 2 3 3 9 | • |

FIGURE 36 - SPECIAL OPERATIONS

JSR, Jump to Subroutine



BSR, Branch to Subroutine



RTS, Return from Subroutine



SP

Stack

RTNI

SWI, Software Interrupt

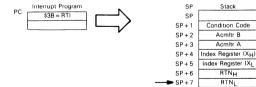
Main Program



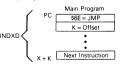
WAI, Wait for Interrupt



RTI, Return from interrupt



JMP, Jump



| , | Main Program |
|-----------------|-------------------------------|
| ſ ^{PC} | \$7E = JMP |
| J | K _H = Next Address |
| Extended | K _L = Next Address |
| L _K | Next Instruction |

Legend

RTN = Address of next instruction in Main Program to be executed upon return from subroutine RTN_H = Most significant byte of Return Address

RTNL = Least significant byte of Return Address

── Stack pointer after execution K = 8-bit unsigned value

CYCLE-BY-CYCLE OPERATION SUMMARY

Table 18 provides a detailed description of the information present on the Address Bus, Data Bus, and the R/\overline{W} line during cycle of each instructions.

The information is useful in comparing actual with expected results during debug of both software and hardware as the program is executed. The information is categorized in groups according to addressing mode and number of cycles per instruction. In general, instructions with the same addressing mode and number of cycles execute in the same manner. Exceptions are indicated in the table.

Note that during MPU reads of internal locations, the resultant value will not appear on the external Data Bus except in Mode 0 "High order" byte refers to the most significant byte of a 16-bit value.

The coding of the first (or only) byte corresponding to an executable instruction is sufficient to identify the instruction and the addressing mode. The hexadecimal equivalents of the binary codes, which result from the translation of the 82 instructions in all valid modes of addressing, are shown in Table 19. There are 220 valid machine codes, 34 unassigned codes and 2 reserved for test purposes.

TABLE 18 - CYCLE BY CYCLE OPERATION

| Address Mode & Instructions | Cycles | Cycle # | Address Bus | R/W Line | Data Bus |
|--|--------|------------|---|-------------|---|
| IMMEDIATE | | | | | <u> </u> |
| ADC EOR ADD LDA AND ORA BIT SBC | 2 | 1 2 | Op Code Address Op Code Address + 1 | 1 1 | Op Code Operand Data |
| CMP SUB | | | | | |
| LDS | 3 | 1 | Op Code Address | 1 | Op Code |
| LDX | | 2 3 | Op Code Address + 1 | 1 ! | Operand Data (High Order Byte |
| LDD | 4 | 1 | Op Code Address + 2 Op Code Address | 1 1 | Operand Data (Low Order Byte) Op Code |
| SUBD | 4 | 2 | Op Code Address + 1 | 1 1 | Op Code Operand Data (High Order Byte |
| ADDD | | 3 | Op Code Address + 2 | l i | Operand Data (Fight Order Byte) |
| | | 4 | Address Bus FFFF | 1 | Low Byte of Restart Vector |
| DIRECT | | | | | |
| ADC EOR | 3 | 1 | Op Code Address | 1 | Op Code |
| ADD LDA | 1 1 | 2 | Op Code Address + 1 | 1 | Address of Operand |
| AND ORA BIT SBC | | 3 | Address of Operand | 1 | Operand Data |
| CMP SUB | | | | | |
| STA | 3 | 1 | Op Code Address | 1 | Op Code |
| | | 2 | Op Code Address + 1 | 1 | Destination Address |
| | | 3 | Destination Address | 0 | Data from Accumulator |
| LDS | 4 | 1 | Op Code Address | 1 | Op Code |
| LDX | 1 1 | 2 3 | Op Code Address + 1 | 1 1 | Address of Operand |
| LDD | | 4 | Address of Operand Operand Address + 1 | 1 1 | Operand Data (High Order Byte Operand Data (Low Order Byte |
| STS | 4 | 1 | Op Code Address | | Op Code |
| STX | , , | 2 | Op Code Address + 1 | l i | Address of Operand |
| STD | | 3 | Address of Operand | lò | Register Data (High Order Byte |
| | | 4 | Address of Operand + 1 | 0 | Register Data (Low Order Byte) |
| CPX | 5 | 1 | Op Code Address | 1 | Op Code |
| SUBD | | 2 | Op Code Address + 1 | 1 | Address of Operand |
| ADDD | | 3 | Operand Address | 1 | Operand Data (High Order Byte |
| | | 4 | Operand Address + 1 | 1 | Operand Data (Low Order Byte |
| | | 5 | Address Bus FFFF | | Low Byte of Restart Vector |
| JSR | 5 | 1 | Op Code Address | 1 | Op Code |
| | | 2 | Op Code Address + 1 | 1 | Irrelevant Data |
| | | 3 4 | Subroutine Address Stack Pointer | 1 | First Subroutine Op Code |
| | | 4 5 | Stack Pointer + 1 | 0 | Return Address (Low Order Byte |
| | | | Total oniter . I | | Return Address (High Order Byte |

- Continued -

TABLE 18 - CYCLE BY CYCLE OPERATION (CONTINUED)

| Address Mode & Instructions | Cycles | Cycle # | Address Bus | R/W Line | Data Bus |
|-----------------------------|-------------|------------|--------------------------------------|-------------|---|
| EXTENDED | | | | | |
| JMP | 3 | 1 | Op Code Address | 1 1 | Op Code |
| | 1 1 | 2 | Op Code Address + 1 | 1 | Jump Address (High Order Byte) |
| | 1 1 | 3 | Op Code Address + 2 | 1 | Jump Address (Low Order Byte) |
| ADC EOR | 4 | 1 | Op Code Address | 1 | Op Code |
| ADD LDA | 1 1 | 2 | Op Code Address + 1 | 1 | Address of Operand |
| AND ORA | 1 1 | 3 | Op Code Address + 2 | 1 | Address of Operand |
| | 1 1 | | | - 1 | (Low Order Byte) |
| BIT SBC CMP SUB | | 4 | Address of Operand | 1 | Operand Data |
| STA | 4 | 1 | Op Code Address | 1 | Op Code |
| | 1 1 | 2 | Op Code Address + 1 | 1 | Destination Address |
| | 1 1 | | i | 1 | (High Order Byte) |
| | 1 1 | 3 | Op Code Address + 2 | 1 | Destination Address |
| | 1 1 | | | | (Low Order Byte) |
| | | 4 | Operand Destination Address | 0 | Data from Accumulator |
| LDS | 5 | 1 | Op Code Address | 1 | Op Code |
| LDX | 1 1 | 2 | Op Code Address + 1 | 1 | Address of Operand |
| | 1 1 | | | ١. | (High Order Byte) |
| LDD | 1 1 | 3 | Op Code Address + 2 | 1 | Address of Operand |
| | 1 1 | 4 | Address of October | ١. | (Low Order Byte) |
| | 1 1 | 5 | Address of Operand | 1 | Operand Data (High Order Byte) |
| 0.70 | ┵ | | Address of Operand + 1 | 1 1 | Operand Data (Low Order Byte) |
| STS | 5 | 1 2 | Op Code Address | 1 1 | Op Code |
| STX | 1 1 | 2 | Op Code Address + 1 | 1 | Address of Operand |
| STD | | 3 | Op Code Address + 2 | 1 | (High Order Byte) Address of Operand |
| 310 | | 3 | Op code Address + 2 | ' | (Low Order Byte) |
| | | 4 | Address of Operand | 0 | Operand Data (High Order Byte) |
| | 1 1 | 5 | Address of Operand + 1 | ١ŏ | Operand Data (Low Order Byte) |
| ASL LSR | 6 | 1 | Op Code Address | +- | Op Code |
| ASR NEG | 1 1 | 2 | Op Code Address + 1 | li | Address of Operand |
| | 1 1 | | | ' | (High Order Byte) |
| CLR ROL | 1 | 3 | Op Code Address + 2 | 1 | Address of Operand |
| | 1 1 | | | 1 | (Low Order Byte) |
| COM ROR | | 4 | Address of Operand | 1 | Current Operand Data |
| DEC TST | | 5 | Address Bus FFFF | 1 | Low Byte of Restart Vector |
| INC | 1 1 | 6 | Address of Operand | 0 | New Operand Data |
| CPX | 6 | 1 | Op Code Address | 1 | Op Code |
| SUBD | 1 1 | 2 | Op Code Address + 1 | 1 | Operand Address |
| | 1 1 | _ | | | (High Order Byte) |
| ADDD | | 3 | Op code Address + 2 | 1 | Operand Address |
| | 1 1 | | | | (Low Order Byte) |
| | | 4 | Operand Address | 1 1 | Operand Data (High Order Byte) |
| | | 5 6 | Operand Address + 1 Address Bus FFFF | 1 1 | Operand Data (Low Order Byte) |
| 100 | | | | | Low Byte of Restart Vector |
| JSR | 6 | 1 2 | Op Code Address | 1 1 | Op Code |
| | | 2 | Op Code Address + 1 | 1 | Address of Subroutine |
| | 1 1 | 3 | Op Code Address + 2 | 1 | (High Order Byte) Address of Subroutine |
| / | 1 | 3 | Op Code Address + Z | ' | (Low Order Byte) |
| | | 4 | Subroutine Starting Address | 1 | Op Code of Next Instruction |
| | | 5 | Stack Pointer | lò | Return Address |
| | 1 1 | • | 1 | ١ | (Low Order Byte) |
| | 1 | 6 | Stack Pointer - 1 | 0 | Return Address |
| | | - | | 1 | (High Order Byte) |

- Continued -

TABLE 18 — CYCLE BY CYCLE OPERATION (CONTINUED)

| Address Mode & Instructions | Cycles | Cycle # | Address Bus | R/W Line | Data Bus |
|-----------------------------|--------|------------|--------------------------------|-------------|----------------------------------|
| INDEXED | | | | | |
| JMP | 3 | 1 | Op Code Address | 1 | Op Code |
| | 1 1 | 2 | Op Code Address + 1 | 1 | Offset |
| | 1 1 | 3 | Address Bus FFFF | 1 | Low Byte of Restart Vector |
| ADC EOR | 4 | 1 | Op Code Address | 1 | Op Code |
| ADD LDA | 1 1 | 2 | Op Code Address + 1 |] 1 | Offset |
| AND ORA | | 3 | Address Bus FFFF | 1 | Low Byte of Restart Vector |
| BIT SBC | 1 | 4 | Index Register Plus Offset | 1 | Operand Data |
| CMP SUB | | | 1 | | |
| STA | 4 | 1 | Op Code Address | 1 | Op Code |
| | 1 1 | 2 | Op Code Address + 1 | 1 | Offset |
| | | 3 | Address Bus FFFF | 1 | Low Byte of Restart Vector |
| | | 4 | Index Register Plus Offset | 0 | Operand Data |
| LDS | 5 | 1 | Op Code Address | 1 | Op Code |
| LDX | | 2 | Op Code Address + 1 | 1 | Offset |
| LDD | | 3 | Address Bus FFFF | 1 | Low Byte of Restart Vector |
| | 1 1 | 4 | Index Register Plus Offset | 1 | Operand Data (High Order Byte) |
| | | 5 | Index Register Plus Offset + 1 | 1 | Operand Data (Low Order Byte) |
| STS | 5 | 1 | Op Code Address | 1 | Op Code |
| STX | | 2 | Op Code Address + 1 | 1 | Offset |
| STD | 1 1 | 3 | Address Bus FFFF | 1 | Low Byte of Restart Vector |
| | 1 1 | 4 | Index Register Plus Offset | 0 | Operand Data (High Order Byte) |
| | | 5 | Index Register Plus Offset + 1 | 0 | Operand Data (Low Order Byte) |
| ASL LSR | 6 | 1 | Op Code Address | 1 | Op Code |
| ASR NEG | | 2 | Op Code Address + 1 | 1 | Offset |
| CLR ROL | | 3 | Address Bus FFFF | 1 | Low Byte of Restart Vector |
| COM ROR | | 4 | Index Register Plus Offset | 1 | Current Operand Data |
| DEC TST (1) | 1 1 | 5 | Address Bus FFFF | 1 | Low Byte of Restart Vector |
| INC | | 6 | Index Register Plus Offset | 0 | New Operand Data |
| CPX | 6 | 1 | Op Code Address | 1 | Op Code |
| SUBD | 1 1 | 2 | Op Code Address + 1 | 1 | Offset |
| ADDD | 1 1 | 3 | Address Bus FFFF | 1 | Low Byte of Restart Vector |
| | | 4 | Index Register + Offset | 1 | Operand Data (High Order Byte) |
| | 1 1 | 5 | Index Register + Offset + 1 | 1 | Operand Data (Low Order Byte) |
| | | 6 | Address Bus FFFF | | Low Byte of Restart Vector |
| JSR | 6 | 1 | Op Code Address | 1 | Op Code |
| | | 2 | Op Code Address + 1 | 1 | Offset |
| | 1 | 3 | Address Bus FFFF | 1 | Low Byte of Restart Vector |
| | 1 1 | 4 | Index Register + Offset | 1 1 | First Subroutine Op Code |
| | | 5 | Stack Pointer | 0 | Return Address (Low Order Byte) |
| | 1 1 | 6 | Stack Pointer - 1 | 1 0 | Return Address (High Order Byte) |

— Continued —

TABLE 18 — CYCLE BY CYCLE OPERATION (CONTINUED)

| Address Mode & Instructions | Cycles | Cycle # | Address Bus | R/W Line | Data Bus |
|---|--------|-----------------------|--|------------------|--|
| INHERENT | | | | | |
| ABA DAA SEC ASL DEC SEI ASR INC SEV CBA LSR TAB CLC NEG TAP CLI NOP TBA CLR ROL TPA CLV ROR TST COM SBA | 2 | 1 2 | Op Code Address Op Code Address +1 | 1 1 | Op Code Op Code of Next Instruction |
| ABX | 3 | 1 2 3 | Op Code Address Op Code Address +1 Address Bus FFFF | 1 1 1 | Op Code Irrelevent Data Low Byte of Restart Vector |
| ASLD LSRD | 3 | 1 2 3 | Op Code Address Op Code Address +1 Address Bus FFFF | 1 1 1 | Op Code Irrelevant Data Low Byte of Restart Vector |
| DES INS | 3 | 1 2 3 | Op Code Address Op Code Address +1 Previous Register Contents | 1 1 1 | Op Code Op Code of Next Instruction Irrelevant Data |
| INX DEX | 3 | 1 2 3 | Op Code Address Op Code Address +1 Address Bus FFFF | 1 1 1 | Op Code Op Code of Next Instruction Low Byte of Restart Vector |
| PSHA PSHB | 3 | 1 2 3 | Op Code Address Op Code Address +1 Stack Pointer | 1 1 0 | Op Code Op Code of Next Instruction Accumulator Data |
| TSX | 3 | 1 2 3 | Op Code Address Op Code Address +1 Stack Pointer | 1 1 1 | Op Code Op Code of Next Instruction Irrelevant Data |
| TXS | 3 | 1 2 3 | Op Code Address Op Code Address +1 Address Bus FFFF | 1 1 1 | Op Code Op Code of Next Instruction Low Byte of Restart Vector |
| PULA PULB | 4 | 1 2 3 4 | Op Code Address Op Code Address +1 Stack Pointer Stack Pointer +1 | 1 1 1 1 | Op Code Op Code of Next Instruction Irrelevant Data Operand Data from Stack |
| PSHX | 4 | 1 2 3 4 | Op Code Address Op Code Address +1 Stack Pointer Stack Pointer -1 | 1 1 0 0 | Op Code Irrelevant Data Index Register (Low Order Byte) Index Register (High Order Byte) |
| PULX | 5 | 1 2 3 4 5 | Op Code Address Op Code Address +1 Stack Pointer Stack Pointer +1 Stack Pointer +2 | 1 1 1 1 | Op Code Irrelevant Data Irrelevant Data Index Register (High Order Byte) Index Register (Low Order Byte) |
| RTS | 5 | 1 2 3 4 5 | Op Code Address Op Code Address +1 Stack Pointer Stack Pointer +1 Stack Pointer +2 | 1 1 1 1 | Op Code Irrelevant Data Irrelevant Data Address of Next Instruction (High Order Byte) Address of Next Instruction (Low Order Byte) |
| WAI | 9 | 1 2 3 4 | Op Code Address Op Code Address +1 Stack Pointer Stack Pointer -1 Stack Pointer -2 | 1 1 0 0 | Op Code Op Code Op Code of Next Instruction Return Address (Low Order Byte) Return Address (High Order Byte) Index Register (Low Order Byte) |
| | | 6 7 8 9 | Stack Pointer -3 Stack Pointer -4 Stack Pointer -5 Stack Pointer -6 | 0 0 0 0 | Index Register (High Order Byte) Contents of Accumulator A Contents of Accumulator B Contents of Cond Code Register |

— Continued —

TABLE 18 - CYCLE BY CYCLE OPERATION (CONTINUED)

| Address Mode & Instructions | Cycles | Cycle # | Address Bus | R∕W Line | Data Bus |
|--------------------------------|--------|------------|-----------------------------|-------------|---|
| INHERENT | | | | | |
| MUL | 10 | 1 | Op Code Address | 1 1 | Op Code |
| | | 2 | Op Code Address +1 | 1 | Irrelevant Data |
| | | 3 | Address Bus FFFF | 1 | Low Byte of Restart Vector |
| | | 4 | Address Bus FFFF | 1 1 | Low Byte of Restart Vector |
| | | 5 | Address Bus FFFF | 1 1 | Low Byte of Restart Vector |
| | | 6 | Address Bus FFFF | 1 1 | Low Byte of Restart Vector |
| | | 7 | Address Bus FFFF | 1 1 | Low Byte of Restart Vector |
| | | 8 | Address Bus FFFF | 1 | Low Byte of Restart Vector |
| | | J 9 | Address Bus FFFF | 1 1 | Low Byte of Restart Vector |
| | | 10 | Address Bus FFFF | 1 | Low Byte of Restart Vector |
| RTI | 10 | 1 | Op Code Address | 1 | Op Code |
| | i | 2 | Op Code Address +1 | 1 | Irrelevant Data |
| | | 3 | Stack Pointer | 1 | Irrelevant Data |
| | 1 | 4 | Stack Pointer +1 | 1 | Contents of Cond Code Reg from Stack |
| | | 5 | Stack Pointer +2 | 1 | Contents of Accumulator B from Stack |
| | | 6 | Stack Pointer +3 | 1 | Contents of Accumulator A from Stack |
| | | 7 | Stack Pointer +4 | 1 | Index Register from Stack (High Order Byte) |
| | | 8 | Stack Pointer +5 | 1 | Index Register from Stack (Low Order Byte) |
| | | 9 | Stack Pointer +6 | 1 | Next Instruction Address from Stack (High Order Byte) |
| | | 10 | Stack Pointer +7 | 1 | Next Instruction Address from Stack (Low Order Byte) |
| SWI | 12 | 1 | Op Code Address | 1 | Op Code |
| | | 2 | Op Code Address +1 | 1 1 | Irrelevant Data |
| | | 3 | Stack Pointer | 0 | Return Address (Low Order Byte) |
| | | 4 | Stack Pointer -1 | 0 | Return Address (High Order Byte) |
| | | 5 | Stack Pointer -2 | 1 0 | Index Register (Low Order Byte) |
| | | 6 | Stack Pointer -3 | اة | Index Register (High Order Byte) |
| | | 7 | Stack Pointer -4 | l o l | Contents of Accumulator A |
| | | 8 | Stack Pointer -5 | 0 | Contents of Accumulator B |
| | | 9 | Stack Pointer -6 | ō | Contents of Cond Code Register |
| | ì | 10 | Stack Pointer -7 | 1 1 | Irrelevant Data |
| • | | 11 | Vector Address FFFA (Hex) | 1 | Address of Subroutine |
| | | 12 | Vector Address FFFB (Hex) | 1 | (High Order Byte) Address of Subroutine |
| RELATIVE | 1 | | | | (Low Order Byte) |
| BCC BHT BNE BLO | 3 | 1 | Op Code Address | 1 1 | Op Code |
| BCS BLE BPL BHS | ° | 2 | Op Code Address +1 | | Branch Offset |
| BEQ BLS BRA BRN BGE BLT BVC | | 3 | Address Bus FFFF | i | Low Byte of Restart Vector |
| BGT BMT BVS | | | | | |
| BSR | 6 | 1 | Op Code Address | 1 | Op Code |
| | | 2 | Op Code Address +1 | 1 | Branch Offset |
| | 1 | 3 | Address Bus FFFF | 1 | Low Byte of Restart Vector |
| | 1 | 4 | Subroutine Starting Address | 1 | Op Code of Next Instruction |
| | | 5 | Stack Pointer | 0 | Return Address (Low Order Byte) |
| | | 6 | Stack Pointer -1 | 0 | Return Address (High Order Byte) |

OP 00 01 # OP MNEM MODE ~ MODE MNEM MODE ~ MNEM MODE MODE CPX SUBB DO D1 ASI 90 90 9E 9F 35 36 37 NOP INHER TXS 69 6A BOI LDS D2 D3 SECE DEC PSHB 6B 6C LSRD 38 39 3A 3B 3C 3D 3E 3F 40 INC TST 40 A1 CHEA INDXD 04 ANDR ASLD CMPA RTS 60 D6 D7 D8 ABX RTI JMP LDAB TAP 3 10 6E 6F A2 SBCA TPA INDXD SUBD STAB INX DEX PSHY NEG EXTND Δ4 ANDA 4 10 70 71 72 73 74 A5 A6 A7 A8 D9 DA BITA ADCB ORAB LDAA CLV WAI SEV 12 STAA DB ADDR COM DC DD LDD CLC SEC NEGA LSR ADCA ORAA STD 41 42 A9 AB AC AD AE AF 75 76 77 78 DE DF ROR LDX SEL 43 COMA ASR ΔΠΠΔ STX E0 E1 SBA LSRA CPX SUBB ASL CMPB CBA 45 ROL JSR 79 7A LDS RORA SBCB ASRA INDXD 78 7C 7D ASLA INC TST B0 B1 SUBA EXTND ANDB E5 E6 BITB 49 TAR 44 DECA JMP B2 SRCA EXTND IMMED TBA B3 B4 STAB SUBD 80 81 82 SUBA CMPA SBCA 40 INCA ANDA B5 B6 BITA LDAA DAA INHER ADCB ORAB INHER SUBD ABA CLRA B7 B8 STAA f.B LDD FORA NEGB 85 86 87 88 89 BITA 89 ADCA ED LDAA BA BB ORAA ADDA L DX STX INDXD сомв 53 54 55 56 57 58 59 5A 5D 5E 5F 60 61 EORA ADCA BC BD CPX JSR LDS SUBB EXTND 20 21 22 23 24 25 26 27 28 29 2A 2B 2C 2D 2E 2F BRA LSRB SBCB RORR 8A 8B ORAA BE EXTND IMMED ADDD ANDB BLS BF STS ASRB CO SUBB IMMED BCC ASLB 8C 8D CPX REL CMPR RITE SBCB LDAB DECB 8E 8F LDS BEQ BVC C3 ADDD STAB ANDB E ORB ADCB INCR 90 91 92 SUBA BVS TSTB CMPA SBCA LDAB ORAB ADDB 93 94 95 CLBB INHER 2 SUBD BGE BLT NEG INDXD ANDA FORR ı nn ADCB ORAB FD STD BITA BGT 96 97 98 99 9A LDAA LDX ADDB STX EXTNO 63 64 65 BLE сом STAA 30 31 TSY LSR EORA ADCA LDD INS CD UNDEFINED OF CODE IMMED LDX 32 PULA ROB ORAA

ADDA

TABLE 19 - CPU INSTRUCTION MAP

NOTES

1 Addressing Modes

² Unassigned opcodes are indicated by "*" and should not be executed

³ Codes marked by "T" force the PC to function as a 16-bit counter

APPENDIX A MC68120 CUSTOM ORDERING INFROMATION

A.0

Address \$FFEF is Reserved for the Checksum value for the ROM, to be generated at the factory.

A.1 CUSTOM MC68120 ORDERING INFORMATION

The custom MC68120 specifications may be transmitted to Motorola in any of the following media:

- A) EPROM(s)
- B) MDOS diskette

The specification should be formatted and packaged, as indicated in the appropriate paragraph below, and mailed prepaid and insured with a cover letter (see Figure A-1) to

Motorola Inc.

MPU Marketing L2787

3501 Ed Bluestein Blvd.

Austin, Texas 78721

A copy of the cover letter should also be mailed separately

A.2 EPROMs

MCM2708 and MCM2716 type EPROMs, programmed with the custom program (positive logic notation for address and data), may be submitted for pattern generation. The

MC2708s must be clearly marked to indicate which PROM corresponds to which address space (\$X800-\$XFFF) See Figure A-2 for recommended marking procedure.

FIGURE A-2





XXX = Customer ID

After the EPROM(s) are marked, they should be placed in conductive IC carriers and securely packed. Do not use styrofoam.

A.3 MDOS DISKETTE

The file name and start/end location should be written on the label

FIGURE A-1

| | GIT I | ZIP |
|---|---|--------------------------------|
| PHONE | EXTENSIO | N |
| CONTACT MS/MR | | |
| CUSTOMER PART # | | |
| ROM START ADDRESS OPTION \$C800 \$D800 | PATTERN MEDIA ☐ 2708 EPROM ☐ 2716 EPROM | TEMPERATURE RANGE ☐ 0° to 70°C |
| □ \$E800 □ \$F800 □ A12 and A13 don't care | ☐ Diskette (MDOS) | PACKAGE TYPE ☐ Ceramic |
| RAM START ADDRESS OPTION | | MARKING ☐ Standard ☐ Special |
| (Note 1) | | |



MC68122 (1.0 MHz) MC68122-1 (1.25 MHz)

Advance Information

MC68122 CLUSTER TERMINAL CONTROLLER

The MC68122 Cluster Terminal Controller (CTC) relieves a host MPU of the time consuming tasks related to communicating with devices such as terminals and line printers. The CTC performs the tasks necessary to handle strings of characters and the proper control functions for communicating with asynchronous, communications-compatible components. The MC68000 asynchronous bus and the MC6800/MC6809 synchronous bus are readily supported by the CTC The CTC provides the host MPU with the following features.

- Automatic Collection of Text Strings During Input, Automatic Transmission of Text Strings During Output
- Broadcast Messages Can Be Sent to All Devices
- Notification of Attention, I/O Request Termination, and Error Conditions
- Wide Range of Control Options Which Can Be Uniquely Specified for Each Device
- Controlled Halting or Ignoring of Output Line Features Available for Interactive Terminals
- Conversational Protocol Between Host MPU and CTC Ideal for Multi-Tasking Implementations
- Operates in Two Configurations: Stand Alone and Expanded
 - Stand Alone An Internal Serial Communications Interface Performs All Data Transfer to a Single Terminal
 - Expanded MC6850 Asynchronous Communications Interface Adapters (ACIA) are Used on the CTC Local Bus
- The Number of Communication Devices May Be Specified at Power-up

MAXIMUM RATINGS

| Rating | Symbol | Value | Unit |
|-----------------------------|------------------|----------------|------|
| Supply Voltage | Vcc | -03 to +70 | ٧ |
| Input Voltage | V _{in} | -0.3 to $+7.0$ | V |
| Operating Temperature Range | TA | 0 to 70 | °C |
| Storage Temperature Range | T _{stg} | -55 to +150 | °C |

THERMAL CHARACTERISTICS

| Characteristic | Symbol | Value | Rating |
|--------------------|-------------------|-------|--------|
| Thermal Resistance | | | |
| Ceramic | $\theta_{\sf JA}$ | 50 | °C/W |

This device contains circuitry to protect the inputs against damage due to high static voltages or electric fields, however, it is advised that normal precautions be taken to avoid application of any voltage higher than maximum rated voltages to this high-impedance circuit. For proper operation it is recommended that V_{In} and V_{Out} be constrained to the range $V_{SS} \leq (V_{In} \text{ or } V_{Out}) \leq V_{CC}$. Reliability of operation is enhanced if unused inputs are tied to an appropriate logic voltage level (e.g., either V_{SS} or V_{CC})

HMOS

(HIGH-DENSITY N-CHANNEL SILICON-GATE)

CLUSTER TERMINAL CONTROLLER



PIN ASSIGNMENTS 48 RESET VSS**□**1 470 C1/SAI Vcc d ∨сс**п**́з 46**b**C2 Εď 45 C3/EI SR/W 05 44 C4 DTACK 06 43 C5 CS d7 42 R/W 41 AS SA7 08 40 A0/D0 SA6 **1**9 SA5 10 39 A1/D1 SA4 11 38 A2/D2 37 A3/D3 V_{CC}**Q**12 SA3 13 36 A4/D4 35 A5/D5 SA2 114 34 DA6/D6 SA1 15 SA0 116 33 A7/D7 32 DA8 SD0 17 SD1 18 31 A9 SD2 🗖 19 30 A10 SD3 120 29 A11 28 A12 SD4 21 SD5 122 27 A13 SD6 123 26 A14 SD7 24 25 A15

Configuration Select Interface Serial Buffer Comm Buffer Int Request Registers System Bus ➤SD5 ►SD6 Address RESET System Data Data Exec SA0 Unit Buffer SAI ystem . SA2 VSS-SA3 Address Address SA4 Transfer Vcc. -545 Area SA6 RAM Address Mux Buffer Buffer A6/D6-A5/D5-A4/D4-A2/D2-A1/D1-A0/D0-AS-Local Bus

FIGURE 1 — CTC FUNCTIONAL BLOCK DIAGRAM

POWER CONSIDERATIONS

The average chip-junction temperature, TJ, in °C can be obtained from

$$T_{J} = T_{A} + (P_{D} \bullet \theta_{J} A)$$
Where:

TA = Ambient Temperature, °C

θ J A ≡ Package Thermal Resistance, Junction-to-Ambient, °C/W

PD = PINT + PPORT

PINT = ICC × VCC, Watts - Chip Internal Power

PPORT≡Port Power Dissipation, Watts - User Determined

For most applications Pport ◀PINT and can be neglected Pport may become significant if the device is configured to drive Darlington bases or sink LED loads.

An approximate relationship between PD and TJ (if PPORT is neglected) is:

$$P_D = K + (T_J + 273 ^{\circ}C)$$
 (2)

Solving equations 1 and 2 for K gives:

 $K = PD \bullet (T_A + 273 \circ C) + \theta JA \bullet PD^2$

Where K is a constant pertaining to the particular part. K can be determined from equation 3 by measuring PD (at equilibrium) for a known T_A. Using this value of K the values of P_D and T_J can be obtained by solving equations (1) and (2) iteratively for any value of TA.

LOCAL BUS ELECTRICAL CHARACTERISTICS ($V_{CC}=5.0~Vdc.+5\%$, $V_{SS}=0$, $T_A=0$ to 70°C unless otherwise noted) (Refer to Figures 2 and 3)

| Characteristic | | Symbol | Min | Тур | Max | Unit |
|---|---|------------------|---|-------------|---------------------|------|
| Input High Voltage | E | VEIH | V _{CC} - 0 75 | _ | Vcc | ٧ |
| Input Low Voltage | E | VEIL | V _{SS} -03 | _ | V _{SS} +06 | ٧ |
| Input High Voltage | RESET Other Inputs* | ViH | V _{SS} +40 V _{SS} +20 | _ | V _{CC} | V |
| Input Low Voltage | All Inputs* | VIL | V _{SS} -03 | _ | V _{SS} +08 | ٧ |
| Input Load Current (V _{In} = 0 to 2 4 V) | AS | l _{in} | - | - | 08 | mA |
| Input Leakage Current (V _{In} = 0 to 5 25 V) | RESET | l _{in} | _ | 15 | 25 | μΑ |
| Three-State (Off State) Input Current (V _{In} = 0 5 to 2 4 V) | SD0-SD7, AD0-AD7, A8-A15, C1-C5 | ^I TSI | _ | 2 0 10 0 | 10 100 | μΑ |
| Output High Voltage (I_Dad = - 205 µA, VCC = Min) (I_Dad = - 146 µA, VCC = Min) (I_Dad = - 100 µA, VCC = Min) | AD0-AD7 A8-A15, R/W Other Outputs | Vон | V _{SS} +24 V _{SS} +24 V _{SS} +24 | - - - | - - - | V |
| Output Low Voltage (I _{Load} = 2 0 mA, V _{CC} = Min) | All Outputs | V _{OL} | - | - | V _{SS} +05 | ٧ |
| Internal Power Dissipation (Measured at TA=0°C) | | PINT | _ | _ | 1200 | mW |
| Input Capacitance $(V_{IR} = 0, T_A = 25$ °C, $f_0 = 1.0$ MHz) | AS Other Inputs | C _{in} | | _ | 12 5 10 0 | pF |

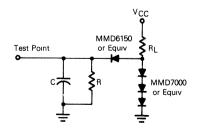
^{*}Except Mode Programming Levels, See Figure 23

DC SYSTEM BUS ELECTRICAL CHARACTERISTICS

 $(V_{CC} = 5.0 \text{ Vdc } \pm 5\%, V_{SS} = 0, T_A = 70^{\circ}\text{C} \text{ unless otherwise noted})$ (Refer to Figure 2)

| | Characteristic | | Symbol | Min | Тур | Max | Unit |
|--|--------------------------|-----------------------|--------|----------------------|-----|---------------------|------|
| Input High Voltage | CS, DTACK, S | A0-SA7, SD0-SD7, SR/W | VIH | Vss+20 | - | Vcc | ٧ |
| Input Low Voltage | CS, DTACK, S | A0-SA7, SD0-SD7, SR/W | VIL | V _{SS} - 03 | | VSS+08 | ٧ |
| Output High Voltage (ILoad = -400) | uA, VCC = min) | DTACK, SD0-SD7 | Voн | V _{SS} + 24 | _ | _ | ٧ |
| Output Low Voltage (I _{Load} = 5 3 mA | , V _{CC} = min) | DTACK, SD0-SD7 | VOL | _ | - | V _{SS} +05 | ٧ |

FIGURE 2 - TIMING TEST LOAD



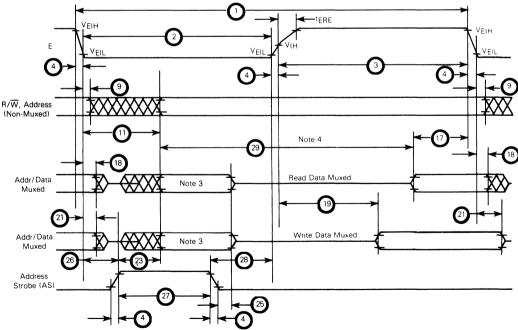
C = 90 pF for AD0-AD7, A8-A15, E, AS, R/W = 130 pF for SD0-SD7, DTACK R = 6 kΩ for SD0-SD7, DTACK = 12 kΩ for AD0-AD7 = 16 5 kΩ for A8-A15, R/W

 $R_L = 2.0 \text{ k}\Omega$ for AD0-AD7, A8-A15, R/W, SA0-SA7 = 750 kΩ for SD0-SD7, DTACK

LOCAL BUS TIMING (Refer to Figures 4 and 15)

| ldent. | 01 | C | MC68122 | | MC68122-1 | | Unit |
|--------|-----------------------------------|---------------------------------|---------|------|-----------|------|------|
| Number | Characteristics | Symbol | Min | Max | Min | Max | Oill |
| 1 | Cycle Time | tcyc | 10 | 20 | 0.8 | 20 | μS |
| 2 | Pulse Width, E Low | PWEL | 430 | 1000 | 360 | 1000 | ns |
| 3 | Pulse Width, E High | PWEH | 450 | 1000 | 360 | 1000 | ns |
| 4 | Clock Rise and Fall Time | t _r , t _f | _ | 25 | _ | 25 | ns |
| 9 - | Non-Multiplexed Address Hold Time | tAH | 20 | - | 20 | _ | ns |
| 11 | Address Delay from E Low | tAD | _ | 260 | _ | 220 | ns |
| 17 | Read Data Setup Time | tDSR | 80 | - | 70 | _ | ns |
| 18 | Read Data Hold Time | ^t DHR | 10 | - | 10 | - | ns |
| 19 | Write Data Delay Time | tDDW | - | 225 | _ | 200 | ns |
| 21 | Write Data Hold Time | tDHW | 20 | _ | 20 | _ | ns |
| 23 | Multiplexed Address Delay from AS | tADM | _ | 90 | _ | 70 | ns |
| 25 | Multiplexed Address Hold Time | tAHL | 20 | 110 | 20 | _ | ns |
| 26 | Delay Time E to AS Rise | tASD | 100 | _ | 80 | _ | ns |
| 27 | Pulse Width, AS High | PWASH | 220 | _ | 170 | _ | ns |
| 28 | Delay Time AS to E Rise | tASED | 100 | _ | 80 | - | ns |
| 29 | Usable Access Time (Note 9) | tACC | 570 | _ | 435 | _ | ns |
| | Enable Rise Time Extended | tere | _ | 80 | _ | 80 | ns |
| | Processor Control Setup Time | tPCS | 200 | _ | 200 | _ | ns |
| | Processor Control Hold Time | tPCH | 20 | 40 | 20 | 40 | ns |

FIGURE 3 - LOCAL BUS TIMING



NOTES

- 1 Voltage levels shown are V_L≤0 5 V, V_H≥2 4 V, unless otherwise specified 2 Measurement points shown are 0.8 V and 2.0 V, unless otherwise specified
- Address valid on the occurrence of the latest of 11 or 23
- Usable access time is computed by: 1 (4+11+17)

ASYNCHRONOUS SYSTEM BUS TIMING (Refer to Figures 54, 5, 6, and 7)

| Characterisic | Symbol | Mın | Тур | Max | Unit |
|--------------------------------------|--------|-----|-----|------------------------|------|
| Cycle Time | tcyc | 0.8 | - | 20 | μS |
| System Address Setup | tSAS | 30 | - | _ | ns |
| System Address Hold | tSAH | 0 | - | _ | ns |
| System Data Delay Read Semaphore | †SDDR | 03 | _ | 0 3+t _{cyc} * | μS |
| RAM | tSDDR | _ | 315 | - | ns |
| System Data Valid | tSDV | 0 | - | _ | ns |
| System Data Hold Read | †SDHR | 30 | - | 90 | ns |
| System Data Delay Write Semaphore | tSDDW | | _ | •• | ns |
| RAM | tSDDW | - | _ | 60 | ns |
| System Data Hold Write | tSDHW | 0 | | _ | ns |
| Data Acknowledge Semaphore | tDAL | 05 | - | 05+t _{cyc} * | μS |
| RAM | tDAL | - | 315 | - | ns |
| Data Acknowledge High | tDAH | _ | _ | 60 | ns |
| Data Acknowledge Three-State | tDAT | _ | - | 90 | ns |
| Data Acknowledge Low to CS High | tDCS | 60 | | _ | ns |

^{*}Actual value dependent upon clock period

FIGURE 4 — ASYNCHRONOUS READ OF SEMAPHORE REGISTER FIGURE

SAO-SA7

CS

SDO-SD7

DTACK

Three State

FIGURE 5 - ASYNCHRONOUS WRITE OF SEMAPHORE REGISTER

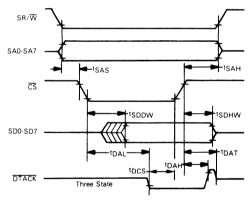


FIGURE 6 - ASYNCHRONOUS READ OF RAM

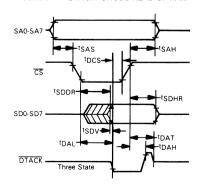
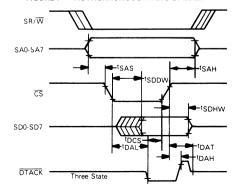


FIGURE 7 — ASYNCHRONOUS WRITE OF RAM



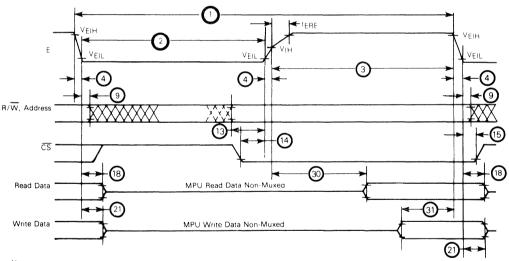
Note Timing measurements are referenced to and from a low voltage of 0.8 volts and a high voltage of 2.0 volts, unless otherwise noted

^{**}Data need not be valid on write to Semaphore Registers

SYNCHRONOUS SYSTEM BUS TIMING (See Notes 1 and 2)

| Ident | Characteristic | Symbol | мс | MC68122 | | MC68122-1 | |
|--------|---------------------------------|---------------------------------|-----|---------|------|-----------|----|
| Number | | · | Min | Max | Min | Max | |
| 1 | Cycle Time | t _{cyc} | 10 | 10 | 0 80 | 10 | μS |
| 2 | Pulse Width, E Low | PWEL | 430 | 9500 | 360 | 9500 | ns |
| 3 | Pulse Width, E High | PWEH | 450 | 9500 | 360 | 9500 | ns |
| 4 | Clock Rise and Fall Time | t _r , t _f | - | 25 | _ | 25 | ns |
| 9 | Address Hold Time | ^t AH | 10 | - | 10 | - | ns |
| 13 | Address Setup Time Before E | tAS | 80 | - | 70 | - | ns |
| 14 | Chip Select Setup Time Before E | tcs | 80 | _ | 70 | _ | ns |
| 15 | Chip Select Hold Time | tCH | 10 | _ | 10 | - | ns |
| 18 | Read Data Hold Time | ^t DHR | 30 | 100 | 30 | 85 | ns |
| 21 | Write Data Hold Time | tDHW | 10 | - | 10 | _ | ns |
| 30 | Output Data Delay Time | [†] DDR | - | 290 | _ | 240 | ns |
| 31 | Input Data Setup Time | ^t DSW | 165 | _ | 120 | _ | ns |
| | Clock Enable Rise Time Extended | †ERE | - | 80 | - | 80 | ns |

FIGURE 8 - SYNCHRONOUS SYSTEM BUS TIMING



- Notes
- 1 Voltage levels shown are V_L \leq 0 5 V, V_H \geq 2 4 V, unless otherwise specified 2 Measurement points shown are 0 8 V and 2 0 V, unless otherwise specified

INTRODUCTION

The CTC is normally used between a host microprocessor (MC68000 or M680X) bus and a local bus consisting of RAM and ACIAs. The number of ACIAs connected to the local bus is determined by the number of devices required, and may be a maximum of 128.

The CTC acts as a "front-end processor" which receives commands and text from a host MPU and then distributes data to and collects data from the appropriate devices connected to the local bus. This data transfer is accomplished by a dual-port RAM area in the CTC known as the Transfer Area RAM. This RAM area is dual ported in that it may be accessed by both the host MPU and by the CTC execution unit Host MPU commands are written to registers within the CTC. The CTC then asynchronously executes the command Status is returned to the host MPU when execution of the command is complete.

The CTC operates in one of two configurations: Stand Alone or Expanded. In the Stand Alone Configuration, no external RAM or ACIAs are required. A single serial port is provided for a device (terminal, printer, etc.) with baud rates provided by the CTC. This configuration is basically provided for user evaluation of the CTC. For systems requiring high data throughput for more than one device, the CTC provides an extra amount of system processing power in the Expanded Configuration

The Expanded Configuration provides servicing of up to 128 ACIAs located on the local bus. These ACIAs can be connected to any serial-type device such as a CRT terminal or line printer. Besides servicing the ACIAs, the CTC also supports the RAM used to contain device parameter information and text distribution areas.

CTC MPU EXECUTION UNIT

The execution unit of the CTC contains an enhanced MC6800 central processing unit. All CTC functions as well as actual program execution within the CTC are totally transparent to the user.

SERIAL COMMUNICATIONS INTERFACE

A full-duplex asynchronous serial communications interface (SCI) is provided in the Stand Alone Configuration with two data formats and a variety of data rates. The SCI transmitter and receiver are functionally independent, but use the same data format and bit rate. Serial data formats include standard mark/space (NRZ) and bi-phase and both provide one start bit, eight data bits, and one stop bit.

TRANSFER AREA

The Transfer Area is accessed from the system bus by using the eight address lines (SA0 through SA7) and the eight data lines (SD0 through SD7). Three control lines (\overline{CS} , $\overline{SR/W}$, \overline{DTACK}) provide either synchronous or asynchronous access to the Transfer Area through the system bus interface. The Transfer Area is selected for either type of access by address lines SA0 through SA7 and the chip select (\overline{CS}) input. The direction of data transfer is selected by the system bus read/write ($\overline{SR/W}$) input. Data Acknowledge (\overline{DTACK}) is the control line used to configure the system bus in either a synchronous or asynchronous interface. When

grounded, $\overline{\text{DTACK}}$ configures the system bus into a synchronous interface. In the asynchronous mode the data transfer acknowledge ($\overline{\text{DTACK}}$) output provides the asynchronous handshake signal required by the MC68000 processor. It can also be used as a memory ready (MRDY) signal for slow memory access on the M6800 Family processors where memory ready capability is provided. Note that if the MRDY signal is to be used with the $\overline{\text{DTACK}}$ signal, the system clock must be faster than, or equal to, the clock driving the CTC.

REQUEST REGISTERS

There are four request registers which can be accessed by the host MPU or the CTC. These registers control the ownership of the Transfer Area RAM, interrupts from the CTC, and other management type functions. The registers are called Lock Register, Parameter Qualification Register, Service Required Register, and Interrupt Request Mirror Register Each register is located at a specific location into the host/CTC address space (see Table 1) Only the most significant bit of each register is used

TABLE 1 — LOCATION OF REGISTERS AND TRANSFER AREA RAM

| Feature | CTC Address |
|----------------------------------|-------------|
| Internal Registers (Reserved) | \$00-\$16 |
| Lock Register | \$17 |
| Parameter Qualification Request | \$18 |
| Service Required Register | \$19 |
| Interrupt Request Mirror Request | \$1A |
| Reserved/Unusable | \$1B-7F |
| Transfer Area RAM | \$80-FF |

^{\$=} Hexadecimal

TRANSFER AREA RAM AND REQUEST REGISTERS

The Transfer Area RAM may be accessed from both the CTC execution unit and the external system bus. The request registers are tools provided for the progammer's use in arbitrating simultaneous accesses of the same resource.*

The CTC's Transfer Area RAM is located from \$0080 through \$00FF

The reserved memory areas \$00-16 and \$1B-7F cannot be written from the system bus and should not be read.

The Transfer Area RAM is accessed from the external system bus by way of eight address lines (SA0-SA7) and eight data lines (SD0-SD7) Three control lines provide for synchronous or asynchronous access to the Transfer Area RAM through port 1 Figure 9 shows an example of a synchronous interface (using MC6809) and Figure 10 shows an example of an asynchronous interface (using MC68000). The dual-ported RAM is selected in each case by address lines SA0-SA7 and chip select (CS) from the system bus. The direction of data transfer is selected by the system read/write (SR/W) line. The data transfer acknowledge (DTACK) signal is the asynchronous handshake required by an MC68000. DTACK can be used to control a memory ready signal on the M6800 Family processor where memory ready capability is provided (see Figure 11). The latter would allow the M6800 Family processor to run asynchronously with the

^{*}These request registers are of the "test and set" variety, i.e., if when read, the register is clear, it will be automatically set. The host processor software must take this into account, and reset the request register in the scanning routine.

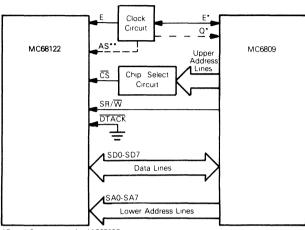


FIGURE 9 - SYNCHRONOUS SYSTEM BUS ACCESS INTERFACE

Clock Circuit MC68122 MC68000 Upper Address Lines Chip Select Circuit Data Strobe SR/W DTACK SD0-SD7 Lower Data Lines SA0-SA7 Lower Address Lines A1-A8

FIGURE 10 - ASYNCHRONOUS SYSTEM BUS INTERFACE

MC68122. It should be noted that if the memory ready signal (on M6800 processors) is to be used with the DTACK signal, the system clock must be faster than or equal to the clock driving the CTC. Example clock circuits are shown in Figures 12 and 13.

LOCK REGISTER

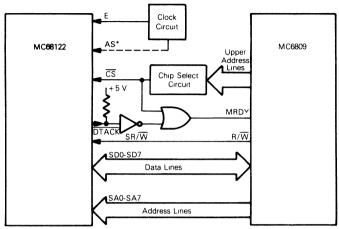
This register, located at \$17, is used in determining ownership of the Transfer Area. When read, the high-order bit indicates one of two results: if set, the Transfer Area was already claimed by the host MPU or is currently under

^{*}E and Q are inputs for MC6809E

^{**}Only needed in Expanded Mode

^{*}Only needed in Expanded Mode

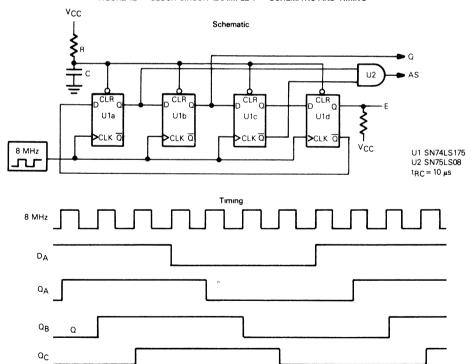
FIGURE 11 - MEMORY READY - DTACK CONFIGURATION

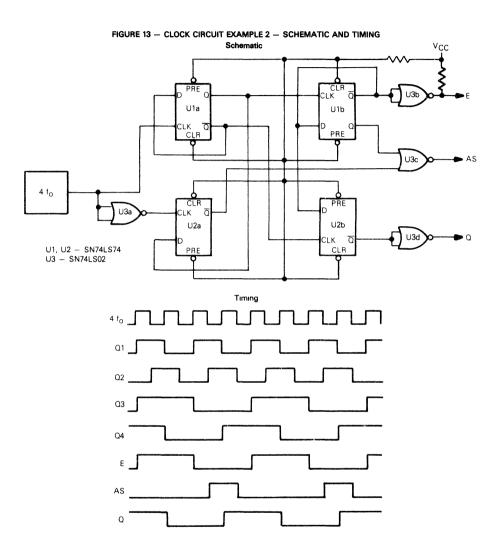


*Only needed in Expanded Mode

Ε

FIGURE 12 - CLOCK CIRCUIT EXAMPLE 1 - SCHEMATIC AND TIMING





ownership of the CTC; if clear, the Transfer Area was free, but now belongs to the host MPU.

The Transfer Area should not be read or written by the host MPU until ownership is obtained.

PARAMETER QUALIFICATION REGISTER

This register, located at \$18, indicates when set that the CTC is in parameter qualification.

SERVICE REQUIRED REGISTER

This register, located at \$19, is set by the host MPU and is used to indicate to the CTC that ownership of the Transfer

Area has now been passed to the CTC and that service is required. The CTC scans this register at least once every millisecond.

INTERRUPT REQUEST MIRROR REGISTER

This register, located at \$1A, is used to mirror the status of the interrupt input. In some systems, where interrupts are either not allowed or not required, a polling routine may be employed by the host MPU to determine when the CTC requires servicing. This latch would be the location scanned to determine if a returned response is ready in the CTC. A zero indicates that host service is required.

FUNCTIONAL PIN DESCRIPTIONS

VCC AND VSS

 V_{CC} and V_{SS} provide power and ground to the CTC. The power supply should provide ± 5 volts ($\pm 5\%$) to V_{CC} and V_{SS} should be tied to ground. Total power dissipation should not exceed P_D milliwatts.

RESET

The reset function is used for three purposes. The first is to provide the CTC with an orderly and defined start-up procedure from a power-down condition. The second is to return to start-up conditions without an intervening power-down condition. The third is to provide a control signal to latch the operating mode.

On the positive edge of RESET, the CTC latches the operating mode from pin C5, the restart vector is fetched and transferred to the program counter, and instruction execution then begins.*

Reset timing is illustrated in Figure 14. The RESET line must be held low for a minimum of three E-cycles for the CTC to complete its entire reset sequence. An external RC network may be used to obtain the required timing.

ENABLE -- E

The E clock input is required for timing to synchronize local data bus transfers. A "CPU E-cycle" (or bus cycle) consists of a negative half-cycle of E followed by a positive half-cycle. For any given bus cycle, the address is valid during the negative half-cycle of E and the selected device must be enabled to the data bus during the next positive half-cycle. The data bus is valid only while E is high. It should be noted that this input shuld have some provision to obtain the specified logical high level which is greater than standard TTL levels.

Enable is the primary CTC system timing signal and all timing data specified as cycles is assumed to be referenced to this clock unless otherwise noted.

SYSTEM BUS INTERFACE

The system bus interface is a configuration-independent 8-bit data port which permits the external system bus to access the Transfer Area RAM and request registers either asynchronously or synchronously with respect to the clock. The complete system interface consists of eight data lines (SDO-SD7), eight address lines (SAO-SA7), and three control lines (SR/W, CS, DTACK).

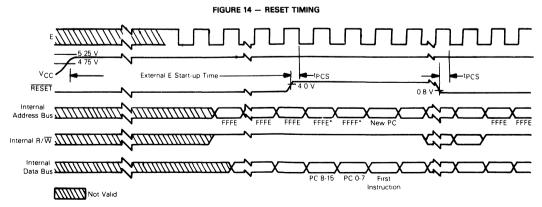
DATA LINES (SD0-SD7) — These bidirectional data lines allow data transfer between the Transfer Area RAM or the request registers, and the system bus. The data bus output drivers are three-state devices which remain in the high-impedance state except during a read of the CTC Transfer Area RAM or request registers by the system processor.

ADDRESS LINES (SA0-SA7) — The address lines, together with the chip select (\overline{CS}) signal, allow any of the 128 bytes of the Transfer Area RAM or the request registers to be uniquely selected. The address lines must be valid before the \overline{CS} signal goes low for the asynchronous transfer and valid before the E signal goes low for the synchronous transfer. The system interface must be deselected between reads or writes for the asynchronous operation.

SYSTEM READ/WRITE (SR/\overline{W}) — This signal is generated by the system bus to control the direction of data transfer on the data bus. With the CTC selected, a low on the SR/\overline{W} line enables the input buffers and data is transferred from the system processor to the CTC. When SR/\overline{W} is high and the chip is selected, the data output buffers are turned on and data is transferred from the CTC to the system bus

CHIP SELECT (CS) — This signal is a TTL-compatible input signal used to activate the system bus interface and

^{*}If operating in the Stand Alone Mode, the serial communications interface formats are latched in on pins 29, 30, 31, and 32 See Tables 3 and 4



NOTE: Timing measurements are referenced to and from a low voltage of 0.8 volts and a high voltage of 2.0 volts, unless otherwise noted

allows transfer of data between the CTC and the system processor during synchronous or asynchronous accesses. CS provides the synchronizing signal for the request registers during access by the system bus

DATA TRANSFER ACKNOWLEDGE (DTACK) — This signal is a handshake line for information transfer on the system data bus in an asynchronous transfer it is generated by the CTC as an acknowledge to the CS signal A low output indicates that valid data is on the bus for transfer during the system read cycle or that data has been written during a system write cycle. The asynchronous operation uses this signal to synchronize the system bus with the CTC processor as illustrated by Figures 4, 5, 6, and 7

A low input on DTACK during the falling edge of CS indicates a synchronous system and data will transfer during the positive level of the system E clock. The timing for this transfer is shown in Figures 12 and 13.

The output characteristics for DTACK are the same as those for the system data bus with allowance for an external pullup resistor Logic characteristics should be such that the external pullup resistor is a holding resistor (i.e., driven to the high level first, then to the high-impedance state).

LOCAL BUS INTERFACE

The local bus interface is used to connect the CTC to local bus components such as RAM, ACIAs, etc., when the CTC is used in the expanded configuration. In the Stand Alone Configuration, this interface is left unconnected

READ/WRITE (R/W)

This signal is used to control the direction of data transfer on the local bus. This pin can drive one Schottky TTL load and 90 pF.

ADDRESS STROBE (AS)

This input signal is used to control the time-multiplexed address/data lines A0-A5/D0-D7 Address strobe may also be used to de-multiplex the two buses for address map ex-

pansion AS is required only in the Expanded Mode of operation. Figure 15 shows how to demultiplex the bus

MULTIPLEXED ADDRESS/DATA BUS (A0-A15/D0-D7)

These sixteen lines function as a multiplexed address/data bus. These lines are held in the high-impedance state between valid address and data times to prevent potential bus conflicts. All lines can drive one Schottky TTL load and 90 pF

OPERATING MODES

The CTC provides two different operating modes which are selectable by hardware programming and are referred to as the Stand Alone Mode, and the Expanded Mode (see Figure 16) The configuration select interface is used to select the operating mode for the CTC. The logic levels present on C5 when the positive edge of the Reset input signal occurs are latched into the CTC and select the appropriate mode. See Figure 20.

In the Stand Alone Configuration, the serial communications interface of the CTC is available at pins 45, 46, and 47 of this interface. Also, an interrupt output is available at pin 43. See Figure 17

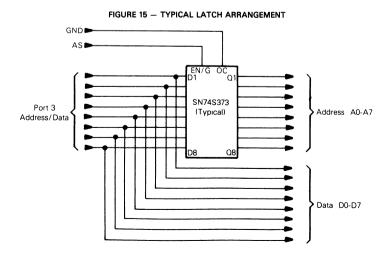
In the expanded configuration, pin 45 is an interrupt output which should be tied to the system interrupt line

Figures 18 and 21 are examples of how the MC68122 is to be used in the Expanded Mode. The Expanded Mode memory map is denoted in Figure 22.

MODE PROGRAMMING

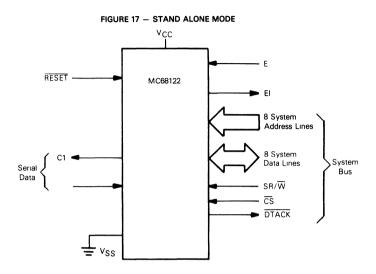
The operating mode is programmed by the level asserted on C5 during the positive edge of $\overline{\text{RESET}}$. See Figure 19 and Table 2.

Circuitry to provide the programming levels is primarily dependent on the normal system use of the three pins. Figure 20 is an example of how to program the modes of the CTC.



6808 6803 68000 6809 6801 6800 6802 RAM Address Data ROM System Bus Expanded Mode MC68122 Local Bus Data RAM MC6850 ACIA (Max = 128)

FIGURE 16 - CTC FUNDAMENTAL OPERATING MODES



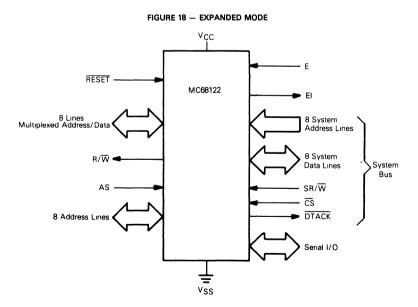


FIGURE 19 - MODE PROGRAMMING TIMING

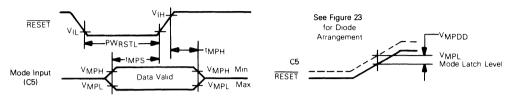


TABLE 2 - MODE PROGRAMMING SPECIFICATIONS (See Figure 20)

| Characteristic | Symbol | Min | Тур | Max | Unit |
|--|--------|-----|-----|-----|----------|
| Mode Programming Input Voltage Low | VMPL | | - | 18 | ٧ |
| Mode Programming Input Voltage High | VMPH | 4 0 | - | - | ٧ |
| Mode Programming Diode Differential (if Diodes are Used) | VMPDD | 06 | | - | ٧ |
| RESET Low Pulse Width | PWRSTL | 3 0 | _ | _ | E-Cycles |
| Mode Programming Setup Time | tMPS | 20 | _ | - | E-Cycles |
| Mode Programming Setup Time | | | | | |
| RESET Rise Time≥1 μs | tMPH | 0 | _ | - | ns |
| RESET Rise Time<1 μs | | 100 | - | | |

FIGURE 20 — TYPICAL MODE PROGRAMMING CIRCUIT

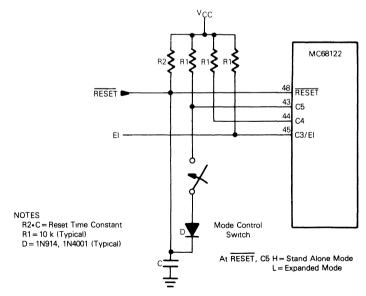
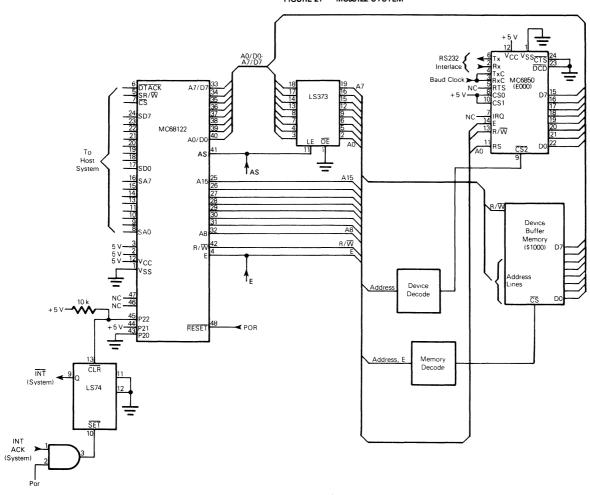
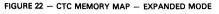
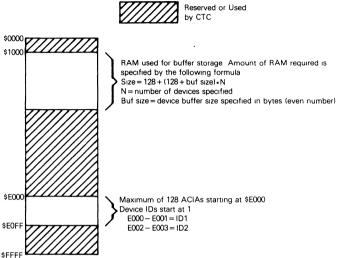


FIGURE 21 - MC68122 SYSTEM



NOTE Figure shows unbuffered system with only one device interface (MC6850) and associated memory





This memory map is the entire 64K map of the CTC. Note that the buffer size should be the maximum data transmitted to or received from a device without host MPU notification required.

NOTE As the Stand Alone Mode of the CTC uses no external RAM or ACIAs, the memory map is irrelevant

INTERRUPTS

The CTC has no user interrupts, but does have lines which are connected to the host MPU for a "shoulder tapping" type of operation. In the Stand Alone Mode, C5 is an interrupt line to the host, while in the Expanded Mode, C3/EI should be used as the interrupt output

SERIAL COMMUNICATIONS INTERFACE

In the Stand Alone Mode, a full-duplex asynchronous serial communications interface is provided for connection to an outside terminal. Two available data formats include the standard mark/space (NRZ) and bi-phase Both formats provide one start bit, eight data bits, and one stop bit

PROGRAMMABLE OPTIONS

The following features of the SCI are programmble

- Format. standard mark/space (NRZ) or bi-phase (see Table 4)
- Clock: external or internal clock source
- Baud rate: one of four per E-clock frequency, or oneeighth of the external clock input to C3 (see Table 3)
- Clock output: internal bit rate clock enabled or disabled to C3

The programmable options listed above are selected by putting specific logic levels on pins 29, 30, 31, and 32 at the time RESET is asserted. Tables 3 and 4 provide the logic level information required for programming the SCI and Figure 23 details two available data formats

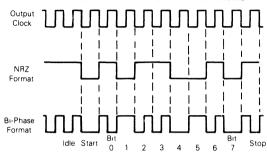
TABLE 3 - SCI BIT TIMES AND RATES (STAND ALONE MODE)

| Pin 32 | Pin 31 | E | 614.4 kHz | 1.0 MHz | 1.2288 MHz |
|--------|--------|--------|-------------------|---------------------|---------------------|
| 0 | 0 | + 16 | 26 μs/38,400 Baud | 16 μs/62,500 Baud | 13 0 μs/76,800 Baud |
| 0 | 1 | + 128 | 208 μs/4,800 Baud | 128 µs/7812.5 Baud | 104 2 μs/9,600 Baud |
| 1 | 0 | + 1024 | 1 67 ms/600 Baud | 1 024 ms/976.6 Baud | 833 3 µs/1,200 Baud |
| 1 | 1 | + 4096 | 6.67 ms/150 Baud | 4 096 ms/244 1 Baud | 3.33 ms/300 Baud |

TABLE 4 - SCI FORMAT AND CLOCK SOURCE CONTROL

| Pin 29 | Pin 30 | Format | Clock | СЗ |
|--------|--------|----------|----------|----------|
| | | | Source | (Pin 45) |
| 0 | 0 | Bı-Phase | Internal | Not Used |
| 0 | 1 | NRZ | Internal | Not Used |
| 1 | 0 | NRZ | Internal | Output |
| 1 | 1 | NRZ | External | Input |

FIGURE 23 - SCI DATA FORMATS (STAND ALONE MODE)



Data 01001101 (\$4D)

MC68122 SYSTEM OPERATION

TRIGGERS

Throughout the following paragraphs, the term "trigger" will appear frequently. This explanation of the trigger concept in data handling is offered to familiarize the CTC user with the concept.

In the trigger concept, the first character is called the match character and the remaining characters are called replacement characters. For triggers associated with input, these characters serve as echoes back to the device, and the echoed characters themselves may activate output triggers. Only the match character is sent to the host MPU, never the echo character Each non-NULL incoming character is compared to the match character, and if matched, the characters following the match are echoed back to the input device. For output, triggers effectively serve as a replacement string.

For example, an input trigger can be set up to provide a carriage return, line feed, and a prompt character as shown

CR - Match Character

CR - Carriage Return

LF - Line Feed

(>) - Prompt Symbol

Whenever a carriage return character is input and matched with the match character of the trigger, the following three items (CR, LF, >) are automatically echoed to the input device

Some triggers perform more complex functions such as backspace control and padding transmission counts. Also, some triggers do not have echo strings or may provide a range of two characters for match determination. The trigger functions are listed in the following pages.

STAND ALONE CONFIGURATION — DETAILED OPERATION

The CTC, while designed for a multi-device system with several ACIAs, can also be used in a Stand Alone Configuration. This configuration gives the designer the capability of evaluating the CTC without requiring several terminals. There is no parameter qualification required in this configuration and the device profile shown below resides completely

in the Transfer Area at all times. There are no default conditions in this configuration. The host must set these values before input or output starts

| Offset into Host/CTC Address Space | Bytes | Function |
|--|-------|-----------------------------------|
| \$80 | 1 | Host Request |
| \$81 | 1 | Error Status Bits (Latched) |
| \$82 | 1 | SCI Status |
| \$83 | 1 | Single Chip Options |
| \$84 | 1 | Output Termination Null Count |
| \$85 | 4 | Output Echo String |
| \$89 | 2 | Input Termination Range |
| \$8B | 1 | Input Termination Match Character |
| \$8C | 1 | Input "AND" Mask Byte |
| \$8D | 4 | Reserved |
| \$91 | 1 | Output/Input Text Length |
| \$92 | 100 | Text Buffer |
| \$F6 | 10 | Internal CTC Use |

FUNCTION DESCRIPTION

\$80 - Host Request

This byte denotes which state the CTC is to enter:

\$00 - idle mode

\$01 - input mode

\$02 - output mode

\$81 - ERROR STATUS BITS

These bits denote any errors which may have occurred on the serial communications interface. This status information is latched for an entire host MPU request.

\$04 - framing error

\$20 - transmitter data register empty

\$40 - overrun/framing error*

\$80 - SCI reads flag - data register contains data

\$82 - SCI STATUS

This byte is a mirror image of the previous byte, only it is continuously updated rather than line by line. Usually only bits \$20 and \$80 are used in this byte.

^{*}Framing error turns on two bits to distinguish it from an overrun error

\$83 - SINGLE CHIP OPTIONS

The options are:

\$40 - echo input termination match character

\$80 - echo input to output

\$84 - OUTPUT TERMINATION NULL COUNT

This byte should be set to the number of nulls required after sending of the output echo string.

\$85 - OUTPUT ECHO STRING

These four bytes represent the output string which is transmitted at the termination of all output text, and when input terminates due to a match with an input termination match trigger. The normal string is a CR, LF combination

\$89 - INPUT END-OF-LINE TERMINATION RANGE

These bytes are used to initiate an end-of-line response to the host MPU when any character or character within a specified range is encountered. No output echo string is sent

\$8B - INPUT END-OF-LINE MATCH CHARACTER

This byte is used to define the end-of-line match character which is commonly a CR. When this character is matched, an output echo string will be transmitted and the input is terminated.

\$8C - INPUT "AND" MASK BYTE

Each character that is entered is automatically ANDed with this byte before further processing. A common value is \$7F, which is normally used to strip off parity bits for seven bit data characters.

\$8D - RESERVED

\$91 — OUTPUT/INPUT TEXT LENGTH

This byte represents the number of bytes that are to be transmitted to/from the host. The number must be within a range from 0 to 100.

\$92 - TEXT BUFFER

These one hundred bytes are used for the text buffer

\$F6 - INTERNAL CTC USE

These 10 bytes are reserved for internal CTC use.

PARAMETER QUALIFICATION — EXPANDED MODE ONLY

Immediately after a Reset, the CTC enters parameter qualification. The parameter qualification register in the CTC addressing space is used to indicate this state, allowing auxiliary "sub-system" resetting local to the CTC to be detected by the host MPU During parameter qualification, certain parameters in the Transfer Area are made available to the host MPU for examination and/or modification. These parameters are, the number of devices being supported, the size of the communications buffer for all devices, and the global default profile values.

Before examining or changing any parameters, the Transfer Area must be owned by setting the Lock Register. When the host MPU is ready to allow the CTC to begin normal processing, it sets the Service Required Register.

EXPANDED CONFIGURATION — DETAILED OPERATION

In the Expanded Mode, there is a self-test feature which can be used at parameter qualification time. By entering a \$06 at the Initialization Mode Switch and setting the Service Required Register, local RAM is checked starting at address \$1000. The address of the first byte of memory which fails self-check is returned at offset \$81 and \$82 within the host/CTC address space segement. This allows functional verification of the RAM on the local bus. After the RAM self-check is completed, the host MPU must again obtain control of the Transfer Area to perform whatever functions were desired during parameter qualification. This time when the transfer area is claimed and the service required register set, the CTC will then begin normal processing and exit parameter qualification mode. The definition of the Transfer Area RAM at this time is:

| | Offset into Host/CTC Address Space | Bytes | Definition |
|-------------------|--|-------|---------------------------------------|
| Control | \$80 | 1 | Initialization Mode Switch |
| Parameter | \$81 | 2 | Result of RAM Self-Test |
| | \$83 | 4 | Reserved |
| | \$87 | 2 2 | Number of Devices |
| , , | \$89 | 2 | Device Buffer Size |
| | \$8B | 4 | Reserved |
| Device Profile | \$8F | 1 | Device Type Options (\$50 = ACIA) |
| Parameter | \$90 | 2 | Attribute Bytes |
| 1 1 | \$92 | 1 | ACIA Control Register |
| 1 1 | | | Parameter |
| | \$93 | 1 | Input "AND" Character Byte |
| | \$94 | 4 | Input End-of-Line Trigger and Echo |
| | \$98 | 4 | Input Backspace Trigger and Echo |
| | \$9C | 5 | Input Misc Trigger and Echo |
| | \$A1 | 5 | Input Cancel-Line Trigger and Echo |
| 1 | \$A6 | 2 | Input Terminate Range Trigger |
| | \$A8 | 2 | Output Carriage Return Null Count |
|] | \$AA | 2 | Output Linefeed Null Count |
| i I | \$AC | 1 | Output Default Nulls |
| 1 1 | \$AD | 5 | Output CR Trigger and Echo |
| | \$B2 | 5 | Output Misc Trigger and |
| | \$B7 | 5 | Echo 1 |
| | ۱۵۶ ا | | Output Misc Trigger and Echo 2 |
| | \$BC | 1 | Output Freeze Control Character |
| 1 | \$BD | 2 | Output Screen Roll Count/Echo |
| | \$BF | 1 | Output Flush Control Character |

The device parameters listed are initialized to default values. These parameters may be changed for each individual device separately during normal processing, or may

be changed for all devices at one time during parameter qualification.

DEVICE PARAMETERS

The location and description of the default values for the device parameters are as follows.

| Offset | Definition/Value |
|--------|---|
| \$8F | Device Type — In the current CTC, this value will always be \$50 |
| \$90 | Attribute Byte 1 — The first attribute byte may be set to any combination of the following values Default value is \$10 \$40 — Inhibit broadcast messages (output only) \$20 — Honor break key during idle \$10 — Echoplex enabled \$08 — Monitor input during idle \$04 — Honor backspace delete (input only) \$02 — Force ASCII upper case (input only) |
| \$91 | Attribute 2 — The second attribute byte is used to denote the following Default value is \$00 \$00 — Accept bad input characters \$40 — Immediate return on input error \$80 — Ignore input error — no echo |

INHIBIT BROADCAST MESSAGES — Some communication devices may be controlling equipment which can be highly sensitive to unwanted text being intermixed with normal transmission to the devices. Examples would be graphics or word processing systems where tightly connected streams of data must be kept pure. Since the CTC broadcast feature may be harmful in such applications, the option can be used to inhibit such interference on a device or global basis

HONOR BREAK KEY — Determines whether the break condition is ignored or notifies the host MPU while in the idle mode Breaks outside of IDLE mode are treated as I/O errors

ECHOPLEX ENABLED — Allows all input characters which do not match triggers to be repeated back to the communications device. Echoed characters may cause output triggers to be activated for text substitutions and null padding extensions.

MONITOR INPUT DURING IDLE — Allows the CTC to automatically go from the idle mode to the input mode if it receives characters from a device

HONOR BACKSPACE DELETE — Causes the previous character received to be deleted from the internal device buffer. If the buffer is empty, the matched input character is ignored.

FORCE ASCII UPPERCASE — Causes all lowercase ASCII characters received to be converted to uppercase characters

ACCEPT BAD INPUT CHARACTER — The CTC will not reject any invalid character due to input errors. They will be echoed if echoplex is enabled. However, at input completion, the status flags will reflect the fact that an input error was detected.

IMMEDIATE RETURN ON INPUT ERROR — The CTC will store the invalid character, flag the error, and terminate input processing. No echoing will be performed

IGNORE INPUT ERROR — **NO ECHO** — The GTC will disregard any invalid character without echoing. However, at input completion, the status flags will reflect the fact that an input error was detected. Default value is \$00

\$92 - ACIA CONTROL REGISTER PARAMETER

This byte controls the mode, number of bits, and parity of each device ACIA. The default value (\$16) represents a divide-by-64 function, with 8 bits, odd parity, and one stop bit. The following tables denote the encoding format:

| В | В0 | Function |
|---|----|----------|
| 0 | 0 | +1 |
| 0 | 1 | ÷ 16 |
| 1 | 0 | - 64 |

| B4 | В3 | B2 | Function |
|----|----|----|------------------------------------|
| 0 | 0 | 0 | 7 Bits + Even Parity + 2 Stop Bits |
| 0 | 0 | 1 | 7 Bits + Odd Parity + 2 Stop Bits |
| 0 | 1 | 0 | 7 Bits + Even Parity + 1 Stop Bit |
| 0 | 1 | 1 | 7 Bits + Odd Parity + 1 Stop Bit |
| 1 | 0 | 0 | 8 Bits + 2 Stop Bits |
| 1 | 0 | 1 | 8 Bits + 1 Stop Bit |
| 1 | 1 | 0 | 8 Bits + Even Parity + 1 Stop Bit |
| 1 | 1 | 1 | 8 Bits + Odd Parity + 1 Stop Bit |

\$93 - INPUT "AND" CHARACTER BYTE

Each character that is entered is automatically ANDed with this byte before further processing. This value may be changed to \$FF, or any other value required. The default value is \$7F, which is normally used to strip off parity bits for seven bit data characters.

\$94 - INPUT END-OF-LINE TRIGGER AND ECHO

The default trigger recognizes a CR and then echoes a CR to terminate the line. Default value is \$0D, \$0D, \$00, \$00. If defaults are unchanged, the output CR trigger echoes both a CR and LF when encountering the CR return from this input trigger. The input mode terminates when this trigger is matched and the echo (if any) completes.

\$98 - INPUT BACKSPACE TRIGGER AND ECHO

The CTC matches on the defined backspace character and echoes to the terminal Default value is \$08, \$08, \$00, \$00. This trigger also causes character deletion from the device buffer if the honor backspace delete attribute is set. If there are no characters in the buffer, the echo is supressed.

\$9C - INPUT MISCELLANEOUS TRIGGER AND ECHO

This trigger is user definable and may be used for any type of input matching. Default value is \$00, \$00, \$00, \$00, \$00, which means this trigger is disabled by default.

\$A1 - INPUT CANCEL-LINE TRIGGER AND ECHO

This trigger, while not enabled by default, allows the device to cancel the previous line of data. Default value is \$00, \$0D, \$00, \$00, \$00. If matched, the complete device buffer is purged, and input mode continues after the echo string is sent. The default echo may express significant text

such as "CAN" or "XXX" Even longer strings may be echoed by having one of these characters trigger a miscellaneous output trigger

\$A6 - INPUT TERMINATE RANGE TRIGGER

This trigger may be set up to terminate the input mode upon reception of any character or any character within a specified range of characters. For example, a range of \$30 to \$39 will cause termination if any ASCII number is entered, a range of \$00 to \$FF will cause termination when any input character is received. Default value is \$00, \$00. A zero second character disables this trigger.

\$A8 - OUTPUT CARRIAGE RETURN NULL COUNT

Whenever this trigger is matched on output, the CTC echoes the specified null count. Default match and count is \$0D, \$05. A zero count is allowed

\$AA - OUTPUT LINEFEED NULL COUNT

Whenever a match is detected on the output, the CTC echoes the specified null count. Default match and count is \$0A, \$02. A zero count is allowed

\$AC - OUTPUT DEFAULT NULLS

This trigger controls how many null characters are sent out after each character. For example, a \$03 placed here would output three nulls after each character except for the matches on CR and LF as just explained Default value is \$00.

\$AD — OUTPUT CARRIAGE RETURN TRIGGER AND ECHO

Upon matching a CR in the output stream, the CTC provides a default CR-LF combination to the device. Default value is \$0D, \$0D, \$0A, \$00, \$00

\$B2 - OUTPUT MISCELLANEOUS TRIGGER AND ECHO 1

This trigger is disabled by default and therefore, not used until redefined by the user. Enough characters are provided for a match character and four echoes. Default value is \$00, \$00, \$00, \$00, \$00.

\$B7 — OUTPUT MISCELLANEOUS TRIGGER AND ECHO 2

This is a second identical output trigger available to the user.

\$BC - OUTPUT FREEZE CONTROL CHARACTER

This trigger allows stopping of any further transmissions from a device when a defined input character is matched. Entering any character will resume transmission. Default value is \$00 (disabled)

\$BD - OUTPUT SCREEN ROLL COUNT/ECHO

This trigger is used to halt transmission of data after a line counter has decremented to zero. Any match of the output CR trigger decrements this counter, or if the last character transmitted for any one request does not match that trigger, the counter is decremented by one. Every read causes this counter to be reset. Data transmission may be resumed by sending any character from the device. The echo character will be displayed every time the display stops. A useful echo character is a bell (\$07). Default value is \$00, \$00.

\$BF - OUTPUT FLUSH CONTROL CHARACTER

At times it is convenient for the operator of a terminal type of communications device to ignore all output messages until the next input request. The CTC offers a flush output option. If, after the completion of any transmitted line to a device, an input character that matches the flush output control character is detected from that device, then the "flush output" condition is set into effect. All output lines for the specified device are ignored. This condition continues until the device is reset by the host, input is requested by the host, or the communications device sends any input to the CTC. Default value is \$00 (disabled)

NORMAL PROCESSING TRANSFER AREA FORMAT

After parameter qualification, the Transfer Area takes on a different function. It is used to send requests to the CTC, and receive request responses back in return. For instance, to write a message to a specific device, several items of control information are required in addition to the actual message text. The following table lists the Transfer Area definition after parameter qualification processing.

| Offset | Bytes | Function |
|--------|-------|------------------------------|
| \$80 | 6 | Reserved |
| \$86 | 1 | Function Requested or |
| | | Function Return Code |
| \$87 | 1 | Device Identification Number |
| \$88 | 1 | Device Status |
| \$89 | 1 | Device Mode |
| \$8A | 2 | Parameter |
| \$8C | 2 | Message Length |
| \$8E | 104 | Message Text Buffer |
| \$F8 | 8 | Reserved |

DATA PROCESSING

Any communications device connected to the CTC is always considered to be in one of three operating modes idle, input, or output. After power-up, reset, and parameter qualification processing, all devices are reset and placed into the idle mode. A device will also be put in the idle mode any time the host MPU requests a reset device service function.

IDLE MODE — Idle mode means that the associated device does not currently have any on-going operations in progress with respect to the host MPU. However, the device may initiate activity on its own. The current setting of the attribute bits for the device determines the type of processing that is to occur if device initiated activity occurs. The attribute bits reside in a double byte and may be examined or reset by the host MPU at any time using the service functions. The following defines the attribute bits, in each device profile, which are relevant to idle processing.

Attribute Byte 1 (\$90)

| Mask Value | Bit Position | Definition |
|------------|--------------|---------------------------|
| \$20 | 1 . | Honor Break Key |
| \$08 | . 1. | Monitor Input During Idle |

If a break condition is detected on the communications line, it will either cause a service interrupt to the host MPU or will be ignored depending on the setting of the mask value. If a service interrupt is generated it will return a function code of 4 (return device profile image) back to the host MPU, and the device will remain in idle mode.

If a character is received, its disposition is determined by the setting of the monitor input during idle bit. If set, the device will immediately go into input mode processing and follow the handling defined for that mode using the character received. If not set, the character is ignored Therefore, the host MPU has the option of allowing automatic switching to the input mode from the idle mode or retaining exclusive control of line turn around conventions

It may be possible for the host MPU to request an output service function at the very same time the device emits a character which switches it to input mode processing. If this occurs, the request of the host MPU for output will be rejected with a function code of 8 (device active) in the Function Return Code register (\$86) Note that the automatic switch from idle mode to input mode and the break monitors are the only type of situation where the host MPU may receive interrupts from a device not directly associated with a request issued to that device

INPUT MODE — A communications device may be placed into input mode in one of two ways. First by the host MPU issuing a read message from device or conversational write service request. The second occurs if the attributes for the device allow monitor input during idle and an input character is received from the device while in the idle state. The input mode is terminated by a match on termination trigger or range termination trigger

A variety of actions may occur during the course of processing input. The attribute bits which are applicable to input mode are

Attribute Byte 1 (\$90)

| | Mask Value | Bit Position | Definition |
|---|------------|--------------|-------------------------|
| | \$10 | 1 | Echoplex Enabled |
| į | \$08 | 1 | Active Backspace Delete |
| | \$02 | 1 | Force ASCII Upper Case |

Attribute Byte 2 (\$91)

| | Mask Value | Bit Position | n Definition | | | | | |
|---|------------|--------------|------------------------------|--|--|--|--|--|
| | \$00 | | Accept Bad Input Character | | | | | |
| į | \$40 | 1 | Immediate Return On Input | | | | | |
| | | | Error | | | | | |
| | \$80 | 1 | Ignore Input Error - No Echo | | | | | |

OUTPUT MODE - A communications device may be placed into output mode in one of two ways: directly by the host MPU requesting that text be sent to the device via the write to device, or conversational write service functions, or indirectly by the issuance of a broadcast message to all

A variety of paths may be taken in the course of processing output. The attribute bits which are applicable to the output mode are

Attribute Byte 1 (\$90)

| Γ | Mask Value | Bit Position | Definition |
|---|------------|--------------|---------------------------|
| ſ | \$01 | 1 | Ignore Broadcast Messages |

CTC RESPONSES TO HOST SERVICE REQUEST

For each function sent to the CTC, a related "completed service" interrupt is returned to the host MPU with information appropriate to the function serviced. However, this interrupt response may not be immediate. Therefore, the CTC may return a "Transfer Area free" interrupt, or if there is a completed service interrupt for any other device, then that completed service interrupt is returned. This guarantees that the host MPU is either immediately notified that the Transfer Area is again free, or that the Transfer Area is now being passed back to the host MPU with a completed service interrupt which may or may not be related to the last requested service

The completed service interrupt always returns at least the device identification and device status fields. Depending on the type of completed service, other information such as text or error status indicators may also be returned

TRANSFER AREA FREE INTERRUPT

After each request is processed the CTC will attempt to return the Transfer Area to the host filled with a return code response from a previous request (or even the same request if possible) However, many times there will not be a response ready for a considerable time. Also, the host may have another request to give to the CTC Therefore, if the CTC finds there is nothing immediately available to return to the host, it returns a special code indicating only that the Transfer Area is now available

After the interrupt the Transfer Area would contain only a return function code of zero

RETURN CODE - 0 indicating Transfer Area can be re-used As with any other CTC interrupt, the Transfer Area is owned by the host implicitly when the interrupt is signaled

SERVICE FUNCTIONS PROVIDED BY THE CTC

Several different types of requests may be made of the CTC Each request must present a function code Some requests may also require a terminal identification number and information in the message text buffer. The following is a list of the service functions available Following this list is detailed information about each service function

Host Request 1 - Write to Device (Fill Device Buffer)

Host Request 2 - Perform Device Read

Host Request 3 - Perform Conversational Write

Host Request 4 - Return Device Profile Image

Host Request 5 - Set Device Profile

Host Request 6 - Reset Device

Host Request 7 - Send Broadcast Message

Host Request 8 - Cold Start the CTC

Host Request 9 - Warm Start the CTC

In describing the contents of the Transfer Area, an X is used to show the variable bit position. When set to a 1, the indicated statement is occurring or has occurred

HOST REQUEST 1 - WRITE TO DEVICE (FILL DEVICE BUFFER)

This request submits text to the CTC for a specific device. The device must be in the idle mode for this request to be initially accepted. The complete text may be passed in segments, in which case all but the first segment is appended to the previous text stored in the device buffer. After final text is received, the CTC transmits the buffer to the associated device allowing output trigger operations and halt/freeze/flush processing. After text transmission, an interrupt will inform the host with an indication in the Transfer Area that the device has completed output processing and is once again in the idle mode. This notification may be delayed due to freeze and roll halt output conditions.

The text may contain embedded control characters and it is up to the host to ensure that the device is properly controlled. Text substitutions and supplemental NULL time-fill padding characters may appear in the actual stream transmitted to the device according to the current device

Once the Transfer Area is owned or being re-used after the CTC has passed it back to the host after an interrupt return. the following fields must be properly initialized

FUNCTION

REQUEST - set to 1 (one) indicating a buffer fill operation

DEVICE ID

- set to the proper device number 1 through N, where N is the total devices specified or defaulted at parameter qualification time

PARM

- must be set to the total remaining text data length to be given to the CTC including the current buffer text When this count is equal to the TEX-TLENGTH count, this indicates to the CTC that this is the last buffer fill and output transmission. should begin. If not equal to TEXTLENGTH, then the CTC will expect yet another buffer fill operation for this device

TEXT-

LENGTH

- the current amount of text characters in the text area This value can range from 0 to the maximum size of 104

TEXTAREA

- the text to be added to the device buffer. If the device was previously in idle mode, the text will be placed at the start of the device buffer and the device will enter output mode. If this is not the first buffer fill request for the device since it left idle mode, then this text is appended to the previous data in the device buffer

Upon completing the field initialization, a request to the CTC is indicated by reading the Service Required Register. This implicitly passes ownership of the Transfer Area to the CTC.

The CTC will eventually return a response to the fill buffer request by interrupting the host with a return code. The possible return codes are:

- RETURN CODE 1 normal output completed for the device The device is in idle mode
 - 3 device buffer appended. This is returned when only a segment of output text is sent to the CTC The CTC will expect more text
 - request rejected, the device is not in idle
 - request rejected, invalid device ID or the text presented would overfill the device output buffer

For codes 1, 3, and 9, where the ID is valid, the following describes the contents of the Transfer Area other than the return code:

DEVICE ID - the device ID in the original request.

STATUS - the current status of the device

> .. X. - device is flushing output

- the current mode for the device

MODE

X - broadcast message is queued

... 10 - device currently in output mode (must be set).

The STATUS and MODE fields are not applicable if the return code is 9 and an invalid device ID was specified in the original request

If the return code is 8, this indicates that the device was in input mode or already transmitting output text from a previous output request. The current mode is indicated by the MODE byte as follows.

MODE - the current mode for the device

1 - device in input processing - device in output processing

HOST REQUEST 2 - PERFORM DEVICE READ

This request allows the specified device to send data to the CTC This function is automatically initiated if the "monitor input during idle" option is set in the device profile and a character is spontaneously received during idle mode Characters received from the device may be echoed and activate input triggers defined for input mode processing as determined by the current profile. The device buffer is filled and input terminated whenever the input end-of-line or range triggers are activated Input errors may also prematurely terminate input processing as defined by the attribute bits in the current device profile. If the device buffer is not large enough to contain all characters received, an input error condition is indicated. An explicit PERFORM DEVICE READ from the host also has the option of presenting two prompt characters which are sent to the device before input is processed. Both the input prompt characters as well as any input trigger echo strings are eligible to trip output triggers

To present this request, the Transfer Area must be owned or being re-used after processing a return function from the CTC. At this time, the following fields must be properly inıtıalızed.

FUNCTION

REQUEST — set to 2 (two), indicating a device read

DEVICE ID - set to the proper device number 1 through N, where N is the total number of devices specified or defaulted at parameter qualification time

PARM

- contains up to two prompt characters to be sent before the read is started. If only one prompt character is to be used, then the second byte must be a NULL If no prompt characters are to be used, then at least the first byte must be a NULL

After initializing the above fields, the request must be sent to the CTC by setting the Service Required Register Eventually the CTC will interrupt the host with a return code for this device. The possible return codes are

RETURN CODE 2 - input completed without error

6 - input aborted due to input error

- input completed with error

- request rejected, device already active

- request rejected, invalid device ID

For codes 2, 6, and 7, text is provided by sending 104 character segments back to the host until the device buffer is exhausted The PARM field indicates the amount of text left to send back to the host including the current text in the Transfer Area. Therefore, when the PARM and TEXT-LENGTH fields contain identical values, the final interrupt response is indicated. If no more than 104 characters were received by the device, then only one response will be generated by the CTC.

The Return Transfer Area for codes 2, 6, and 7 is as follows

RETURN

CODE - 2, 6, or 7 as explained above

DEVICE ID - the device ID in the original request

STATUS - the input status of the device

X — device buffer overflowed
X — input parity error detected
X — input overrun error detected
X — input framing error detected

MODE - the current device mode

X - broadcast message is queued

1 - input mode

PARM — the remaining text length to send to the host *includ-ing* the current text buffer. If not equal to TEXT-LENGTH, then the CTC will send more text with an-

other response interrupt

TEXT-

LENGTH — count of current text in TEXTBUFFER Will be from 1 to 104

- contains the text received from the device

Note that return code 2 will never have the error indicators on in the status byte. For return code 6, the error indicators will pertain to the last character received and sent to the host from the device buffer. Return code 5 indicates that error(s) occurred somewhere during the reception of the data. Also, note that the first Response Transfer Area PARM will contain the total count of characters received from the device. The host may use this for dynamic buffer allocation and the like.

If the return code is 8, this indicates that the device was already in input or output mode. The current mode is indicated by the MODE byte as follows.

MODE - the current mode for the device

0 1 — device in input processing
1 0 — device in output processing

Only the RETURN CODE and DEVICE ID fields are applicable if the return code is 9 as an invalid device ID was specified in the original request

HOST REQUEST 3 — PERFORM CONVERSATIONAL WRITE

A conversational write is like the normal fill buffer function, but after text transmission to the device is completed, a read device request is internally generated by the CTC. Thus, when the host has the foreknowledge of a pending read after the current write, it can avoid processing the normal "output done" interrupt by having a read queued for activation after the current write completes. The conversational write is also useful when a complicated prompt needs to be performed before a read to a device, and the two character prompt for the normal read is found to be too limiting even if expanded with an output miscellaneous trigger.

Conversational write is exactly like a combination of WRITE TO DEVICE followed by READ DEVICE except that the two character input prompt is not available.

This request first submits text to the CTC for a specific device. The device must be in the idle mode for this request to be accepted. The complete text may be passed in segments, in which case all but the first is appended to the previous text stored in the device buffer. After final text is received, the CTC transmits the buffer to the associated device allowing output trigger operations and halt/freeze/flush processing. After text transmission, READ

DEVICE processing will automatically be activated. This activation may be delayed due to freeze or roll halt output conditions.

The text sent may contain embedded control characters and it is up to the host to ensure that the device is properly controlled. Text substitutions and supplemental NULL time-fill padding characters may appear in the actual stream transmitted to the device according to the current device profile.

Once the Transfer Area is owned or being re-used after the CTC has passed it back to the host after an interrupt return, the following fields must be properly initialized.

FUNCTION

REQUEST — set to 3 (three) indicating conversational write buffer fill operation

DEVICE ID — set to the proper device number 1 through N, where
N is the total devices specified or defaulted at parameter qualification time

PARM — must be set to the total remaining text length to be given to the CTC *including* the current buffer text When this count is equal to the TEXTLENGTH count, it indicates to the CTC that this is the last buffer fill and output transmission should begin If not equal to TEXTLENGTH, then the CTC will expect

another buffer fill operation for this device

TEXT-

LENGTH — the current amount of text characters in the text area. This value can range from 0 to the maximum size of 104

TEXTAREA — the text to be added to the device buffer. If the device was previously in idle mode, the text will be placed at the start of the device buffer and the device will enter output mode. If this is not the first buffer fill request for the device since it left idle mode, then this text is appended to the previous data in the device buffer.

Upon completing the field initialization, a request to the CTC is indicated by reading the Service Required Register. This implicitly passes ownership of the Transfer Area to the CTC

If the CTC immediately returns a response interrupt to the host, then one of the following return codes will be presented:

RETURN CODE 3 — device buffer appended. This is returned when only a segment of output text is sent to the CTC. The CTC will expect more

text

request rejected, the device is not in idle mode

 request rejected, invalid device ID or the

 request rejected, invalid device ID or the text presented would overfill the device output buffer

For a code of 3 or 9 where the ID is valid, the following describes the contents of the Transfer Area other than the return code:

DEVICE ID — the device ID is the original request

STATUS - the current status of the device

X. — device is flushing output

MODE - the current mode for the device:

. X – broadcast message is queued
1 . – device currently in output mode

The STATUS and MODE fields are not applicable if the return code is 9 and an invalid device ID was specified in the original request.

If the return code is 8, this indicates that the device was in input mode or already transmitting output text from a previous output request. The current mode is indicated by the MODE byte as follows

MODE - the current mode for the device 1 - device in input processing 1 - device in output processing

If the last request completed sending output text to the CTC, then a response will not come back until that output is transmitted and an automatic read has been completed Then the return codes are the same as those for the READ DEVICE function request

During the read, the CTC allows the specified device to send data to the CTC. Characters received from the device may be echoed and activate input triggers defined for input mode processing as determined by the current profile. The device buffer is filled and input terminated whenever the input end-of-line or range triggers are activated. Input errors may also prematurely terminate input processing as defined by the attribute bits in the current device profile. If the device buffer is not large enough to contain all characters received, then this is handled as an input error condition. If input characters are echoed as determined by the current device profile, then they may activate output triggers as a result.

After the read request terminates, these additional return codes may be sent to the host via a return code interrupt.

RETURN CODE 2 - input completed without error - input aborted due to input error

- input completed with error

For any return, text is provided by sending 104 character segments to the host until the device buffer is exhausted. The PARM field indicates the amount of text left to send back to the host including the current text in the Transfer Area Therefore, when the PARM and TEXTLENGTH fields contain identical values, the final interrupt response is indicated. If no more than 104 characters were received by the device, then only one response will be generated by the CTC

The Return Transfer Area for these codes are as follows:

RETURN CODE

2, 6, or 7 as explained above

DEVICE ID - the device ID in the original request

STATUS

- the input status of the device: - device buffer overflowed х

- input parity error detected - input overrun error detected - input framing error detected

MODE - the current device mode

X - broadcast message is queued

1 - input mode - conversational write

PARM

- the remaining text length to send to the host including the current text buffer. If not equal to TEXT-LENGTH, then the CTC will send more text with another response interrupt

TFXT-LENGTH

- count of current text in TEXTBUFFER Will be from 1 to 104

TEXT-

BUFFER

- contains the text received from the device

Note that return code 2 will never have the error indicators on in the status byte. For return code 6, the error indicators will pertain to the last character received and sent to the host from the device buffer. Return code 5 indicates that error(s) occurred somewhere during the reception of the data. Also note that the first Response Transfer Area PARM will contain the total count of characters received from the device The host may use this for dynamic buffer allocation and the

HOST REQUEST 4 - RETURN DEVICE PROFILE IMAGE

The host may, at any time, investigate the current status, mode, and profile for any device. The profile contains input and output triggers along with several other types of device related control information and attributes. The host also has the privilege of setting the device profile at any time the device is in idle mode

To obtain this information, the Transfer Area is first obtained by either claiming it by successfully setting the Lock Register, or by re-using it after the CTC has presented it to the host with return information from a previous request The following fields must be properly initialized

FUNCTION

REQUEST - set to 4 (four) indicating a return profile request is underway

DEVICE ID - set to the desired device number from 1 to N, where N is the total number of devices allowed at parameter qualification time

After the above fields are filled in, the Service Required Register is set by reading it. This causes the function request to be presented to the CTC.

The CTC will respond with an interrupt, returning the following information:

RETURN

CODE - 5 indicating this is responding to a profile image re-

auest

DEVICE ID - the device ID in the original request

STATUS - the current device status

- device buffer input overflowed

- input parity error detected - input overrun detected

- input framing error detected x - output device has requested flush

state (output ignored) - output device is in wait due to a Х freeze command or roll output count has decre-

mented to zero MODE - current device mode

a conversational write is in progress

00 - currently in idle mode 1 - currently in output mode

1 - currenly in input mode X - broadcast message is gueued

TEXT-

LENGTH - the length of the profile image returned in TEXT-BUFFFR

TFXT-

BUFFER - an image of the current device profile

This image of the profile may conveniently be altered and used to change the device profile by issuing the SET DEVICE PROFILE request as the image is in the same position as required by the CTC for that function.

HOST REQUEST 5 - SET DEVICE PROFILE

This function is used whenever the host desires to change or set the profile for a specific device. Usually it is used after issuing the RETURN DEVICE PROFILE request. In essence, the device profile is reinitalized to the image supplied.

In most cases the new profile options take effect immediately. However, a few need to have the device reset with the RESET DEVICE request function. Changing the ACIA control register value requires the device to be reset, as only at that time is the control register loaded. If the current roll wait count is altered, then it will take effect at the next read. If this is unacceptable, then the device may be reset with RESET DEVICE and the new count will take effect immediately.

The Transfer Area must be assigned to the host by setting the Lock Register or re-using the Transfer Area after it is passed back to the host from a CTC return interrupt. The following fields should then be initialized.

FUNCTION

REQUEST - 5 indicating the device profile is to be changed

DEVICE ID - set to the desired device ID. This must be a value from 1 to N where N is the maximum devices allowed at parameter qualification

TFXT-LENGTH

- length of the profile to be changed, starting from the first byte. If the length is shorter than the available profile length, then the reset will remain unaltered

TEXT-

- the image representing the new device profile

After initializing the above fields, the CTC is notified that a request is available by setting the Service Required Register The CTC will return with an interrupt and a return code of one of the following

RETURN CODE 5 - new profile accepted and image returned 8

- request rejected, the device is not in idle mode - request rejected, invalid device ID

If the return code is 5, then the following fields are available in the transfer buffer.

DEVICE ID - the device ID in the original request

STATUS - the current device status

> X - device has requested output flush (output ignored)

MODE - current device mode

00 - device in idle mode X - broadcast is queued to device

TEXT-

LENGTH - the length of the profile image returned in TEXT-BUFFER

TEXT-

- an image of the current device profile

If the return code is 8, this indicates that the device was in input or output mode. The current mode is indicated by the MODE byte as follows:

MODE - the current mode for the device 1 - device in input processing
1 - device in output processing

If code 9 is returned, then only the DEVICE ID field is applicable as there is no such device.

HOST REQUEST 6 - RESET DEVICE

The host may at times wish to terminate current processing, or force certain profile changes to take effect immediately. These are both accomplished with the RESET DEVICE request. This function operates regardless of the current status or mode of the device. The device is forced into idle mode and any outstanding request for that device is terminated without notification. This is true even if the device buffer is partially filled or emptied in response to a WRITE or READ DEVICE request, or the device was in an output wait due to freeze or roll halt states

The final result is that the device is totally reinitialized as though from parameter qualification, except that the current profile remains intact. The device ACIA has its control register reloaded with the value from the current profile. Note that if the ACIA was still actively transmitting a character, then that character may be incorrectly terminated.

To initiate the function, the Transfer Area must be owned by setting the Lock Register or by re-using it after processing a CTC initiated interrupt. Then the following two fields must be properly initialized.

FUNCTION

REQUEST - 6 indicating a device reset

DEVICE ID - set to the desired device ID from 1 to N where N is the maximum allowed at parameter qualification time

At this time the Service Required Register must be set to indicate to the CTC that a request is available. The CTC will respond with an interrupt containing the following items in the Transfer Area.

RETURN

CODE - 5 current status and profile being returned

DEVICE ID - same as that issued in the request

STATUS - current device status

- no errors or output conditions

MODE current device mode

0 - no conversational write in progress 00 - device in idle mode

0 - no broadcast queued to device

TEXT-

LENGTH - length of the device profile image given in TEXT-BUFFFR

TFXT-

BUFFER

- an image of the current device profile as defined in the chapter on profiles

HOST REQUEST 7 - SEND BROADCAST MESSAGE

The CTC broadcast message facility allows text to be sent to all devices. Any device in idle mode immediately converts it to output mode and the CTC starts sending the text. Devices not in idle mode will convert and receive text the next time the idle mode is entered. The text may contain em' edded control characters (thus making them possibly multi-lined) and must be from 0 to 104 bytes in length. A length of zero inactivates the broadcast facility. Devices may ignore broadcast if their profiles have been set with attribute bits specifying that broadcasts are to be inhibited.

After obtaining ownership of the Transfer Area, the following fields must be properly initialized:

FUNCTION

REQUEST - 7 indicating broadcast text.

TFXT-

LENGTH

- set to the length of the text from 0 to 104 If zero, then broadcasts are temporarily inhibited. If more than 104, then 104 is used.

TEXT-

BUFFER - contains the broadcast text if non-zero length.

Once the above fields are initialized, the Service Required

Register must be set to signal to the CTC that a request is ready to process.

This CTC request is one which does not return an overt interrupt. The request is taken to be satisfied immediately. Of course, the CTC will respond with an interrupt eventually to notify the host that the Transfer Area is free or with a return code from the result of a different request.

HOST REQUEST 8 - COLD START THE CTC

For certain purposes the host may wish to completely restart CTC processing. This could be done by having hardware hold the Reset line low, or by requesting the CTC to perform a restart on its own. This request causes the host to abandon all processing and act as though a hardware reset is underway. This request is available at any time after parameter qualification. The Interrupt Request Mirror Register is set, the Parameter Qualification Register is set, the Service Required Register is cleared, the Lock Register is set, and then parameter qualification begins again exactly as though from a power-up reset state.

After obtaining the Transfer Area, only the function request code need be specified:

FUNCTION REQUEST — 8 indicating a cold start CTC request

No interrupt response is generated as parameter qualification is immediately entered.

HOST REQUEST 9 - WARM START THE CTC

The host may effect a reset on all devices belonging to the CTC, in effect, causing a global reset. The WARM START function performs this service. This function operates regardless of any device status or mode. All devices are forced into idle mode and all outstanding requests are terminated without notification.

The final result is that all devices are totally reinitialized as though from parameter qualification, except that all current profiles remain intact. All device ACIAs have their control registers reloaded with the values from their current profiles Note that if any ACIAs are still actively transmitting a character, then that character may be incorrectly transmitted.

To initiate the function, the Transfer Area must be owned by setting the Lock Register or by re-using it after processing a CTC initiated interrupt. Then the following field must be properly initialized.

FUNCTION REQUEST - 9 indicating a CTC warm start

The Service Required Register must be set to indicate to the CTC that a request is available.

This CTC request is one which does not return an overt interrupt. The request is taken to be satisfied immediately. Of course, the CTC will respond with an interrupt eventually to notify the host that the Transfer Area is free or with a return code from the result of a different request.

FIGURE 24
The following equate table represents the Transfer Area RAM in packed form

| | * CTC FUNCTION F | | |
|---|------------------|------------------------|--------------------------------------|
| 0000001 | FNMSG EQU | 1 | FILE DEVICE BUFFFR |
| 00000002 | FNINFT EQU | ? | READ DEVICE |
| 0000003 | FNCONV EQU | 3 | CONVERSATIONAL WRITE |
| 0000004 | FNFROF EQU | 4 | REQUEST DEVICE PROFILE |
| 00000005 | FNSETP EQU | 5 | SET DEVICE PROFILE |
| 00000006 | FNRST EQU | 6 | RESET DEVICE |
| 00000007 | FNBRD EQU | 7 | BROADCAST SERVICE |
| 00000008 | FNCRS EQU | 8 | COLD RESET CTC |
| 0000009 | FNWRS EQU | 9 | WARM RESET CTC |
| 00005000 | ORG | SHRCPY | |
| | * PARAMETER QUAL | IFICATION TRANSFER ARE | A LAYOUT |
| 00005000 00000001 | IMODE DS.B | 1 | HOST PO FUNCTION REQUEST |
| 00005001 00000002 | THIRAM DS.E | 2 | HIGH RAM CHECK RETURN ADDRESS |
| 00005003 00000002 | IDFADR DS.B | 2 | |
| 00005005 00000002 | IDFSTK DS.B | 2 | |
| 00005007 00000002 | INTNOV DS.B | 2 2 2 | NUMBER OF DEVICES |
| 00005009 00000002 | INTEFS DS.E | 2 | DEFAULT BUFFER SIZE |
| 0000500B 00000002 | INTTEP DS.B | 2 | DEFAULT TASK ENTRY POINT |
| 0000500D 00000002 | INTTCB DS.B | 2 | DEFAULT START OF TASK CONTROL BLOCKS |
| *************************************** | | ILT DEVICE PROFILE | |
| 0000500F 00000001 | INTDEV DS.B | 1 | DEVICE ID (\$50) |
| 00005010 00000001 | INTAT1 DS.B | 1 | ATTRIBUTE BYTE ONE |
| 00005011 00000001 | INTAT2 DS.B | ī | ATTRIBUTE BYTE TWO |
| 00005012 00000001 | INTACN DS.B | ī | ACIA CONTROL REGISTER |
| 00005013 00000001 | INTIAB DS.B | 1 | INPUT "AND" BYTE |
| 00005014 00000004 | INTLTT DS.B | 4 | INPUT LINE TERMINATOR TRIGGER |
| 00005018 00000004 | INTEST DS.B | 4 | INPUT BACKSPACE TRIGGER |
| 0000501C 00000005 | INTMST DS.B | | INPUT MISCELANEOUS TRIGGER |
| 00005021 00000005 | INTENT DS.B | 5 | INPUT CANCEL LINE TRIGGER |
| 00005026 00000002 | INTRGT DS.B | 5 5 2 2 | INPUT RANGE TERMINATOR |
| 00005028 00000002 | INTERN DS.B | 2 | INPUT CARRIAGE RETURN NULL COUNT |
| 0000502A 00000002 | INTLFN DS.B | 2 | INPUT LINEFEED NULL COUNT |
| 0000502C 00000001 | INTDGN DS.B | ī | INPUT DEFAULT NULL COUNT |
| 0000502D 00000005 | INTCRT DS.B | 5 | OUTPUT CARRIAGE RETURN TRIGGER |
| | | | |

FIGURE 24 (CONTINUED)

```
OUTPUT MISCELANOUS TRIGGER ONE OUTPUT MISCELANOUS TRIGGER TWO
00005032 00000005
                          TNTM1 T
                                    DS.E
                                               5
00005037 00000005
                          INTM2T
                                    DS.B
                                               5
0000503C 00000001
                          INTERZ
                                    DS.B
                                                                          OUTPUT FREEZE CONTROL CHARACTER
0000503D 00000002
                          THISRC
                                    DS.B
                                               2
                                                                         OUTPUT SCREEN ROLL COUNT AND ECHO
0000503F 00000001
                          TNTFI S
                                    DS.E
                                               1
                                                                         OUTPUT FLUSH CONTROL CHARACTER
          00005000
                                    ORG
                                               SHRCPY
                          * TRANSFER AREA NORMAL EXECUTION DEFINITION
00005000 00000006
                                    DS.B
                                                                          KESERVED
00005006 00000001
                          YENCTN
                                    DS.F
                                               1
                                                                          FUNCTION CODE
00005007 00000001
                          XDTD
                                    DS.B
                                                                         DEVICE ID
DEVICE STATUS
00005008 00000001
                          XSTAT
                                    DS.E
                                               1
00005009 00000001
                          XMODE
                                    DS.B
                                                                          DEVICE MODE
0000500A 00000002
                          YEARM
                                    DS.B
                                               2
                                                                          PARAMETER
0000500C 00000002
                          XMSGI.N
                                               2
                                    DS.B
                                                                          TEXT LENGTH
0000500F 00000066
                          XMSG
                                    DS.E
                                               102
                                                                          TEXT
00005074 00000000
                                    DS.B
          0000500E
                                    ORG
                                               XMSC
                          * DEVICE
                                    PROFILE TRANSFER AREA I AYOUT
0000500F 00000001
                          XF RDEV
                                    DS.B
                                                                          DEVICE ID ($50)
0000500F 00000001
                          VEDAT1
                                    DS.B
                                                                         ATTRIBUTE BYTE ONE.
ATTRIBUTE BYTE TWO
00005010 00000001
                          XFRAT2
                                    DS.E
                                               1
00005011 00000001
                          XFRACN
                                    DS.B
                                                                         ACIA CONTROL REGISTER
INPUT "AND" BYTE
                                               1
00005012 00000001
                          XFRIAB
                                     DS.B
00005013 00000004
                                                                          INPUT I INE TERMINATUR TRIGGER
                          XFRLTT
                                    DS.B
00005017 00000004
00005018 00000005
                                                                         INPUT BACKSPACE TRIGGER
INPUT MISCELANEOUS TRIGGER
                          XERRST
                                    DS.B
                                               4
                          XERMST
                                    DS.B
                                               5
                                                                         INPUT MISCELANEOUS TRIGGER
INPUT CANCEL LINE TRIGGER
INPUT RANGE TERMINATOR
INPUT CARRIAGE RETURN NULL COUNT
INPUT LINEFEED NULL COUNT
INPUT DEFAULT NULL COUNT
00005020 00000005
                          XFRCNT
                                     DS.B
                                               5222
00005025 00000002
00005027 00000002
                          XFRRGT
                                     DS.B
                          XERCEN
                                    DS.B
00005029 00000002
                          XFRLFN
                                    DS.B
0000502B 00000001
                          XFRDGN
                                     DS.E
                                               1
00005020 00000005
                          YERCRT
                                    DS.B
                                               5
                                                                          OUTPUT CARRIAGE RETURN IRIGGER
                                                                         OUTPUT MISCELANOUS TRIGGER ONE
OUTPUT MISCELANOUS TRIGGER TWO
00005031 00000005
                          YERMIT
                                    DS. E
                                               17
00005036 00000005
                                               5
                          XFRM2T
                                    DS.B
                                                                         OUTPUT FREEZE CONTROL CHARACTER
OUTPUT SCRFEN ROLL COUNT AND ECHO
0000503B 00000001
                          XFRFRZ
                                    DS.B
0000503C 00000002
0000503E 00000001
                          YERSRC
                                    DS.B
                                               2
                          YEREL S
                                    DS.E
                                                                         OUTPUT FLUSH CONTROL CHARACTER
                          * TRANSFER AREA DEFINITION (SINGLE-CHIP MODE) *
                          ****************
          00005000
                                    ORG
                                               SHRCRY
00005000 00000001
                          SCHREQ
                                                                          HOST REQUEST
                                    DS.B
                          SCERRL
00005001 00000001
                                                                          FRROR BTTS (LATCHED)
                                     DS.B
00005002 00000001
                          SCSTAT
                                    DS.B
                                               1
                                                                          SCI STATUS
                                                                          SINGLE-CHIP OPTIONS
00005003 00000001
                          SCORTS
                                    DS.B
                                               1
00005004 00000001
                          SCONUL
                                                                          OUTPUT TERMINATION NULL COUNT
                                    DS.E
00005005 00000004
                          SCECHO
                                    DS.B
                                                                          OUTPUT ECHO STRING
          00000004
                          SCECHI
                                    EQU
                                               X-SCECHO
                                                                          LENGTH OF ECHO STRING
                                                                         INPUT END-OF-LINE TERMINATION RANGE
INPUT END-OF-LINE MATCH CHARACTER
INPUT 'AND' MASK BYTE
00005009 00000002
                          SCIEL R
                                    DS.B
                                               2
00005008 00000001
                          SCIELM
                                    DS.B
0000500C 00000001
                          SCIAND
                                    DS.B
0000500D 00000004
                                    DS.B
                                                                          RESERVED
00005011 00000001
                          SCTLEN
                                    DS.B
                                                                          OUTPUT/INPUT TEXT LENGTH
00005012 00000064
                          SCIEVE
                                    DS. B
                                               100
                                                                         TEXT BUFFER MAXIMUM LENGTH TEXT
          00000064
                          SCTMAX
                                    EQU
                                               *-SCTEXT
00005076 0000000A
                                     DS.E
                                                                          CTC SINGLE-CHIP STACK
          0000507F
                          SCSTK
                                    EQU
                          * STATUS/LATCH DEFINITIONS *
                          *******
          00000080
                          SCSRDF
                                    EQU
                                               $80
                                                                          SCI READER LLAG
          00000040
                          SCSOFF
                                    EQU
                                               $40
                                                                          OVERRUNZHRAMING ERROR
          00000020
                          SCSTRE
                                    FOLL
                                               $20
                                                                          TRANSMITTER DATA RECISIER EMPTY
          00000004
                          SCSEME
                                    EGU
                                               $04
                                                                         FRAMING ERROR
                          *****
                          * OPTIONS BYTE *
                          ******
          00000080
                          SCOECI
                                    EQU
                                               $80
                                                                          ECHO INPUT TO OUTPUT (ECHOPLEX)
          00000040
                          SCOF IM
                                    FOLI
                                               $40
                                                                          ECHO INPUT MATCH CHARACTER
```



MC68230L8 MC68230L10

Advance Information

MC68230 PARALLEL INTERFACE/TIMER

The MC68230 Parallel Interface/Timer provides versatile double buffered parallel interfaces and an operating system oriented timer to MC68000 systems The parallel interfaces operate in unidirectional or bidirectional modes, either 8 or 16 bits wide. In the unidirectional modes, an associated data direction register determines whether the port pins are inputs or outputs. In the bidirectional modes the data direction registers are ignored and the direction is determined dynamically by the state of four handshake pins. These programmable handshake pins provide an interface flexible enough for connection to a wide variety of low, medium, or high speed peripherals or other computer systems. The PI/T ports allow use of vectored or autovectored interrupts, and also provide a DMA Request pin for connection to the MC68450 Direct Memory Access Controller or a similar circuit. The PI/T timer contains a 24-bit wide counter and a 5-bit prescaler. The timer may be clocked by the system clock (PI/T CLK pin) or by an external clock (TIN pip), and a 5-bit prescaler can be used. It can generate periodic interrepts, a square wave, or a single interrupt after a programmed time period. Also it can be used for elapsed time measurement or as a device watchdog

- MC68000 Bus Compatible
- Port Modes Include
 Bit I/O

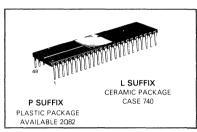
Unidirectonal 8-Bit and 16-Bit Bidirectional 8-Bit and 16-Bit

- Selectable Handshaking Options
- 24-Bit Programmable Timer
- Software Programmable Timer Modes
- Contains Interrupt Vector Generation Logic
- Separate Port and Timer Interrupt Service Requests
- Registers are Read/Write and Directly Addressable
- Registers are Addressed for MOVEP (Move Peripheral) and DMAC Compatibility

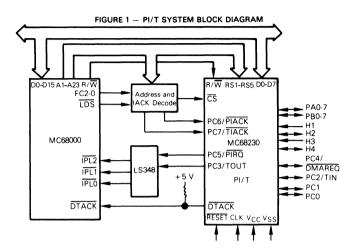
HMOS

(HIGH-DENSITY N-CHANNEL SILICON-GATE)

PARALLEL INTERFACE/TIMER



| PIN ASSIGNMENT | | | | | | | | |
|----------------|----|----|--------------|--|--|--|--|--|
| D5 D | | 48 | D4 | | | | | |
| D6 🖸 | 2 | 47 | D3 | | | | | |
| D7 C | 3 | 46 | D D2 | | | | | |
| PA0 [| 4 | 45 | D D1 | | | | | |
| PA1 [| 5 | 44 | D D0 | | | | | |
| PA2 🕻 | 6 | 43 | n r∕₩ | | | | | |
| РАЗ 🕻 | 7 | 42 | DTACK | | | | | |
| PA4 [| 8 | 41 | p cs | | | | | |
| PA5 [| 9 | 40 | CLK | | | | | |
| PA6 [| 10 | 39 | RESET | | | | | |
| PA7 [| 11 | 38 | p ∨ss | | | | | |
| ∨cc ⊑ | 12 | 37 | PC7/TIACK | | | | | |
| н1 🗖 | 13 | 36 | PC6/PIACK | | | | | |
| н2 🗖 | 14 | 35 | PC5/PIRQ | | | | | |
| нз 🗖 | 15 | 34 | PC4/DMAREQ | | | | | |
| н4 🗖 | 16 | 33 | р РСЗ/ТОИТ | | | | | |
| РВ0 Д | 17 | 32 | PC2/TIN | | | | | |
| PB1 [| 18 | 31 | P C1 | | | | | |
| РВ2 🕻 | 19 | 30 | PC0 | | | | | |
| РВЗ □ | 20 | 29 | RS1 | | | | | |
| РВ4 🕻 | 21 | 28 | RS2 | | | | | |
| РВ5 🕻 | 22 | 27 | RS3 | | | | | |
| РВ6 □ | 23 | 26 | 1 RS4 | | | | | |
| РВ7 С | 24 | 25 | RS5 | | | | | |
| - | | | | | | | | |



POWER CONSIDERATIONS

The average chip-junction temperature, T.J. in °C can be obtained from.

$$T_{J} = T_{A} + (P_{D} \bullet \theta_{JA}) \tag{1}$$

Where:

TA = Ambient Temperature, °C

θ J A = Package Thermal Resistance, Junction-to-Ambient, °C/W

PD = PINT + PPORT

PINT≡ICC×VCC, Watts - Chip Internal Power

PPORT = Port Power Dissipation, Watts - User Determined

For most applications PPORT

PINT and can be neglected PPORT may become significant if the device is configured to drive Darlington bases or sink LED loads.

(2)

An approximate relationship between PD and TJ (if PPORT is neglected) is.

$$P_D = K + (T_J + 273^{\circ}C)$$

Solving equations 1 and 2 for K gives.

$$K = P_D \bullet (T_A + 273^{\circ}C) + \theta_J A \bullet P_D^2$$
(3)

Where K is a constant pertaining to the particular part. K can be determined from equation 3 by measuring PD (at equilibrium) for a known TA. Using this value of K the values of PD and TJ can be obtained by solving equations (1) and (2) iteratively for any value of TA.

MAXIMUM RATINGS

| 117001110111111111111111111111111111111 | | | |
|---|------------------|----------------|------|
| Characteristics | Symbol | Value | Unit |
| Supply Voltage | Vcc | -0.3 to +7.0 | ٧ |
| Input Voltage | V _{in} | -0.3 to +7.0 | V |
| Operating Temperature Range | TA | 0 to 70 | °C |
| Storage Temperature | T _{sta} | - 55 to + 150 | °C |

THERMAL CHARACTERISTICS

| Characteristics | Symbol | Value | Rating |
|--------------------|-------------|-------|--------|
| Thermal Resistance | | | |
| Ceramic | θ JA | 50 | °C/W |

This device contains circuitry to protect the inputs against damage due to high static voltages or electric fields, however, it is advised that normal precuations be taken to avoid application of any voltage higher than maximum-rated voltages to this high-impedance circuit. Reliability of operation is enhanced if unused inputs are tied to an appropriate logic voltage level (e.g., either VSS or VCC).

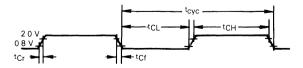
DC ELECTRICAL CHARACTERISTICS ($V_{CC} = 5.0 \text{ Vdc } \pm 5\%$, $T_A = 0 \text{ to } 70 ^{\circ}\text{C}$ unless otherwise noted)

| Characteristics | | | | | | | | |
|---|---|------------------|---------------------|-------------|----------|--|--|--|
| Input High Voltage | All Inputs | VIH | VSS+20 | Vcc | ٧ | | | |
| Input Low Voltage | All Inputs | VIL | V _S S-03 | Vss+08 | V | | | |
| Input Leakage Current (V _{In} = 0 to 5 25 V) H1, H3, | R/W, RESET, CLK, RS1-RS5, CS | l _{in} | _ | 10 0 | μА | | | |
| Three-State (Off State) Input Current ($V_{IN} = 0.4$ to 2.4 | DTACK, PC0-PC7, D0-D7 H2, H4, PA0-PA7, PB0-PB7 | ^I TSI | _ _0 1 | 20 - 1 0 | μA mA | | | |
| Output High Voltage (ILoad = -400 µA, V _{CC} = min) (ILoad = -150 µA, V _{CC} = min) (ILoad = -100 µA, V _{CC} = min) | DTACK, D0-D7 H2, H4, PB0-PB7, PA0-PA7 PC0-PC7 | ∨он | V _{SS} +24 | _ | ٧ | | | |
| Output Low Voltage (ILoad = 8 8 mA, V _{CC} = min) (ILoad = 5 3 mA, V _{CC} = min) (ILoad = 2 4 mA, V _{CC} = min) PA0-PA7, PB0-PB7 | PC3/TOUT, PC5/ <u>PIRQ</u> D0-D7, <u>DTACK</u> , H2, H4, PC0-PC2, PC4, PC6, PC7 | V _{OL} | | 05 | ٧ | | | |
| Internal Power Dissipation (Measured at TA = 0°C) | | PINT | | 500 | mW | | | |
| Input Capacitance (V _{In} = 0, T _A = 25°C, f = 1 MHz) | | C _{in} | _ | 15 | pF | | | |

CLOCK TIMING (See Figure 2)

| Characteristic | Symbol | 8 MHz MC68230L8 | | 10 MHz MC68230L10 | | Unit |
|---------------------------|------------------------------------|--------------------|------------|----------------------|------------|------|
| | | Min | Max | Mın | Max | |
| Frequency of Operation | f | 2 0 | 8 0 | 2 0 | 10 0 | MHz |
| Cycle Time | t _{cyc} | 125 | 500 | 100 | 500 | ns |
| Clock Pulse Width | ^t CL ^t CH | 55 55 | 250 250 | 45 45 | 250 250 | ns |
| Clock Rise and Fall Times | t _{Cr} t _{Cf} | _ | 10 10 | _ | 10 10 | ns |

FIGURE 2 - INPUT CLOCK WAVEFORM



AC ELECTRICAL CHARACTERISTICS (VCC=5 0 Vdc $\pm 5\%$, VSS=0 Vdc, TA=0°C to 70°C)

| Number | Characteristic | 8 N | //Hz 1230L8 | l . | MHz 230L10 | Unit |
|--------------|--|-----|----------------|-----|---------------|---------------|
| | | Min | Max | Min | Max | 1 |
| 1 | R/W, RS1-RS5 Valid to CS Low (Setup Time) | 0 | _ | 0 | - | ns |
| 2(11) | CS Low to R/W and RS1-RS5 Invalid (Hold Time) | 100 | | 65 | - | ns |
| 3(1) | CS Low to CLK Low (Setup Time) | 30 | - | 20 | _ | ns |
| 4(2) | CS Low to Data Out Valid (Delay) | _ | 75 | _ | 60 | ns |
| 5 | RS1-RS5 Valid to Data Out Valid (Delay) | _ | 140 | _ | 100 | ns |
| 6 | CLK Low to DTACK Low (Read/Write Cycle) (Delay) | 0 | 70 | 0 | 60 | ns |
| 7(3) | DTACK Low to CS High (Hold Time) | 0 | _ | 0 | - | ns |
| 8 | CS High to Data Out Invalid (Hold Time) | 0 | - | 0 | _ | ns |
| 9 | CS High to D0-D7 High-Impedance (Delay) | _ | 50 | - | 45 | ns |
| 10 | CS or PIACK or TIACK High to DTACK High (Delay) | | 50 | _ | 30 | ns |
| 11 | CS or PIACK or TIACK High to DTACK High Impedance (Delay) | _ | 100 | - | 55 | ns |
| 12 | Data In Valid to CS Low (Setup Time) | 0 | - | 0 | - | ns |
| 13 | CS Low to Data In Invalid (Hold Time) | 100 | _ | 65 | _ | ns |
| 14 | Input Data Valid to H1(H3) Asserted (Setup Time) | 100 | _ | 60 | _ | ns |
| 15 | H1(H3) Asserted to Input Data Invalid (Hold Time) | 20 | _ | 20 | _ | ns |
| 16 | Handshake Input (H1-H4) Pulse Width Asserted | 40 | | 40 | T - | ns |
| 17 | Handshake Input (H1-H4) Pulse Width Negated | 40 | - | 40 | T - | ns |
| 18 | H1(H3) Asserted to H2(H4) Negated (Delay) | _ | 150 | _ | 120 | ns |
| .19 | CLK Low to H2(H4) Asserted (Delay) | _ | 100 | _ | 100 | ns |
| 20(4) | H2(H4) Asserted to H1(H3) Asserted | 0 | | 0 | | ns |
| 21(5) | CLK Low to H2(H4) Pulse Negated (Delay) | | 125 | _ | 125 | ns |
| 22(10) | H1(H3) Asserted to DMAREQ Low (See Figures 13 and 14) | | 25 | _ | 2 5 | CLK Per (12) |
| 23 | DMAREQ Pulse Width Low | 3 | - | 3 | - | CLK Per (12) |
| 24 | CLK Low to Output Data Valid (Delay) (Modes 0, 1) | | 150 | | 120 | ns |
| 25 | H1(H3) Asserted to Output Data Invalid (Modes 0, 1) | 15 | _ | 15 | | CLK Per (12) |
| 26 | H1 Negated to Output Data Valid (Modes 2, 3) | _ | 70 | _ | 50 | ns |
| 27 | H1 Asserted to Output Data High-Impedance (Modes 2, 3) | 0 | 70 | 0 | 70 | ns |
| 28 | Read Data Valid to DTACK Low (Setup Time) | 0 | | 0 | T - | ns |
| 29 | CLK low to Data Output Valid (Interrupt Acknowledge Cycle) | _ | 120 | _ | 100 | ns |
| 30(7) | H1(H3) Asserted to CLK High (Setup Time) | 50 | I - | 40 | T - | ns |
| 31 | PIACK or TIACK Low to CLK Low (Setup Time) | 50 | _ | 40 | _ | ns |
| 32 | CS Low to DMAREQ Low (Delay) (See Figures 13 and 14) | _ | 3 | _ | 3 | CLK Per (12) |
| 33(10) | H2(H4) Negated to H2(H4) Asserted (Interlocked) | 3 5 | - | 3 5 | _ | CLK Per (12) |
| 34 | CLK Low to DTACK Low (Interrupt Acknowledge Cycle) (Delay) | _ | 75 | _ | 60 | ns |
| 35 | CLK Low to DMAREQ Low (Delay) | 0 | 120 | 0 | 100 | ns |
| 36 | CLK Low to DMAREQ High (Delay) | 0 | 120 | 0 | 100 | ns |
| _ | CLK Low to PIRQ Low or High-Impedance | | 200 | | 150 | ns |
| – (8) | TIN Frequency (External Clock) — Prescaler Used | 0 | 1 | 0 | 1 | Fclk (Hz) (6) |
| – (9) | TIN Frequency (External Clock) - Prescaler Not Used | 0 | 1/32 | 0 | 1/32 | Fclk (Hz) (6) |
| _ | TIN Pulse Width High or Low (External Clock) | 55 | | 45 | - | ns |
| - | TIN Pulse Width Low (Run/Halt Control) | 1 | | 1 | I - | CLK |
| _ | CLK Low to TOUT High, Low, or High-Impedance | 0 | 200 | 0 | 150 | ns |
| _ | CS, PIACK, or TIACK High to CS, PIACK, or TIACK Low | 50 | _ | 30 | _ | ns |

NOTES

¹ This specification only applies if the PI/T had completed all operations initiated by the previous bus cycle when \overline{CS} was asserted Following a normal read or write bus cycle, all operations are complete within three CLKs after the falling edge of the CLK pin on which \overline{DTACK} was asserted If \overline{CS} is asserted prior to completion of these operations, the new bus cycle, and hence, \overline{DTACK} is postponed

If all operations of the previous bus cycle were complete when $\overline{\text{CS}}$ was asserted, this specification is made only to insure that $\overline{\text{DTACK}}$ is asserted with respect to the falling edge of the CLK pin as shown in the timing diagram, not to guarantee operation of the part. If the $\overline{\text{CS}}$ setup time is violated, $\overline{\text{DTACK}}$ may be asserted as shown, or may be asserted one clock cycle later.

 $^{\,2\,}$ Assuming the RS1-RS5 to Data Valid time has also expired

- 3 This specification imposes a lower bound on \overline{CS} low time, guaranteeing that \overline{CS} will be low for at least 1 CLK period
- 4 This specification assures recognition of the asserted edge of H1(H3)
- 5 This specification applies only when a pulsed handshake option is chosen and the pulse is not shortened due to an early asserted edge of H1(H3)
- 6 CLK refers to the actual frequency of the CLK pin, not the maximum allowable CLK frequency
- 7 If timing number 30 is violated, H1(H3) will be recognized no later than the next rising edge of the clock
- 8 This limit applies to the frequency of the signal at TIN compared to the frequency of the CLK signal during each clock cycle. If any period of the waveform at TIN is smaller than the period of the CLK signal at that instant, then it is likely that the timer circuit will completely ignore one cycle of the TIN signal. Since the frequency measured by a frequency counter is the average frequency of a signal over a specific length of time, the actual frequency at any one time will vary above and below the average. These variations occur in both the TIN and CLK signals.

If these two signals are derived from different sources they will have different instantaneous frequency variations. In this case the frequency applied to the TIN pin must be distinctly less than the frequency at the CLK pin to avoid lost cycles of the TIN signal. Measurements have shown that with signals derived from different crystal oscillators applied to the TIN and CLK pins with fast rise and fall times. The TIN frequency can approach 80 to 90% of the frequency of the CLK signal without a loss of a cycle of the TIN signal.

If these two signals are derived from the same frequency source then the frequency of the signal applied to TIN can be 100% of the frequency at the CLK pin. They may be generated by different buffers from the same signal or one may be an inverted version of the other. The TIN signal may be generated by an 'AND' function of the clock and a control signal.

- 9 This limit applies in every case. There are no exceptions to this specification
- 10 If a bus access and peripheral access occur at the same time, add one clock to specifications 22 and 33
- 11 See BUS INTERFACE CONNECTION section for exception
- 12 This Limit specifies the nominal output timing in PI/T clock cycles. To obtain the output timing in nanoseconds, add or subtract the appropriate setup time and/or propagation time from the signals to the respective clock edges.

CLK
R/W
RS1-RS5
DO-D7
DTACK
DMAREQ

FIGURE 3 BUS READ CYCLE TIMING

NOTE Timing measurements are referenced to and from a low voltage of 0.8 volts and a high voltage of 2.0 volts, unless otherwise noted

FIGURE 4 - BUS WRITE CYCLE TIMING

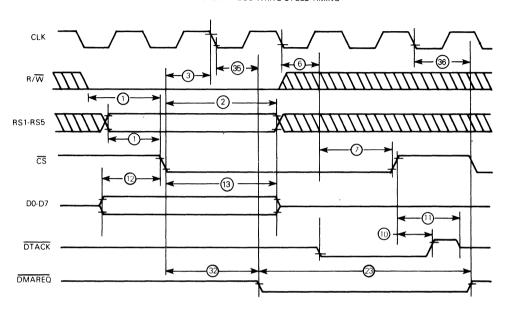
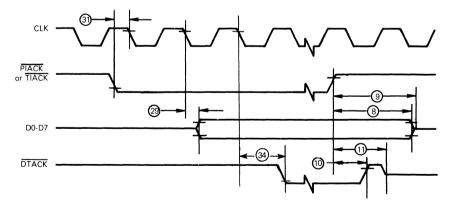


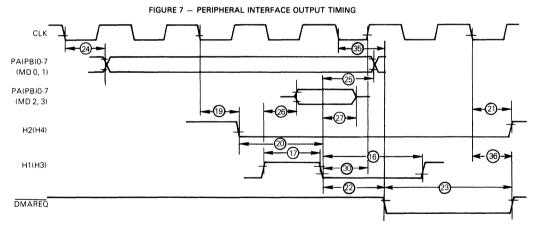
FIGURE 5 — INTERRUPT ACKNOWLEDGE FUNCTIONAL TIMING DIAGRAM



Note Timing measurements are referenced to and from a low voltage of 0.8 volts and a high voltage of 2.0 volts, unless otherwise noted

PA(PB)0-7 H1(H3) H2(H4) DMAREQ

FIGURE 6 - PERIPHERAL INTERFACE INPUT TIMING



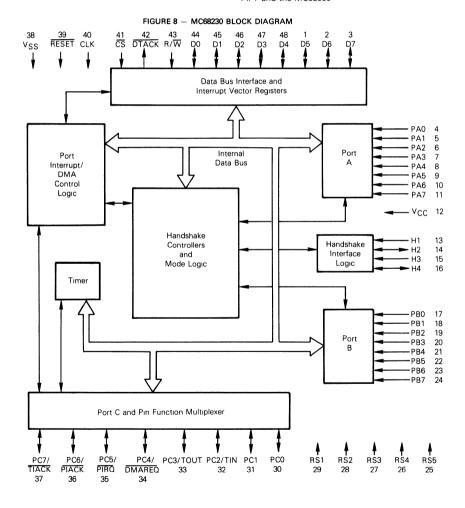
NOTE Timing measurements are referenced to and from a low voltage of 0.8 volts and a high voltage of 2.0 volts, unless otherwise noted

GENERAL DESCRIPTION

The PI/T consists of two logically independent sections the ports and the timer. The port section consists of Port A (PA0-7), Port B (PB0-7), four handshake pins (H1, H2, H3, and H4), two general I/O pins, and six dual-function pins. The dual-function pins can individually operate as a third port (Port C) or an alternate function related to either Ports A and B, or the timer. The four programmable handshake pins, depending on the mode, can control data transfer to and from the ports, or can be used as interrupt generating inputs, or 1/O pins.

The timer consists of a 24-bit counter, optionally clocked by a 5-bit prescaler. Three pins provide complete timer I/O PC2/TIN, PC3/TOUT, and PC7/TIACK. Of course, only the ones needed for the given configuration perform the timer function, while the others remain Port C I/O

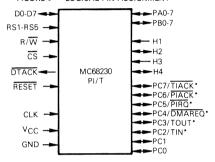
The system bus interface provides for asynchronous transfer of data from the PI/T to a bus master over the data bus (D0-D7) Data transfer acknowledge (\overline{DTACK}), register selects (RS1-RS5), chip select, the read/write line (R/\overline{W}), and Port Interrup Acknowledge (\overline{PIACK}) or Timer Interrupt Acknowledge (\overline{TIACK}) control data transfer between the PI/T and the MC68000



PI/T PIN DESCRIPTION

Throughout the data sheet, signals are presented using the terms active and inactive or asserted and negated independent of whether the signal is active in the high-voltage state or low-voltage state (The active state of each logic pin is given below.) Active low signals are denoted by a superscript bar R/\overline{W} indicates a write is active low and a read active high

FIGURE 9 - LOGICAL PIN ASSIGNMENT



*Individually Programmable Dual-Function Pin

D0-D7 — Bidirectional Data Bus The data bus pins D0-D7 form an 8-bit bidirectional data bus to/from the MC68000 or other bus master. These pins are active high

RS1-RS5 — Register Selects RS1-RS5 are active high high-impedance inputs that determine which of the 25 possible registers is being addressed. They are provided by the MC68000 or other bus master.

 R/\overline{W} — Read/Write Input — R/\overline{W} is the high-impedance Read/Write signal from the MC68000 or bus master, indicating whether the current bus cycle is a read (high) or write (low) cycle

 $\overline{\text{CS}}$ — Chip Select Input $\overline{\text{CS}}$ is a high-impedance input that selects the PI/T registers for the current bus cycle. Address strobe and the data strobe (upper or lower) of the bus master, along with the appropriate address bits, must be included in the chip select equation. A low level corresponds to an asserted chip select.

DTACK — Data Transfer Acknowledge Output DTACK is an active low output that signals the completion of the bus cycle During read or interrupt acknowledge cycles, DTACK is asserted by the MC68230 after data has been provided on the data bus, during write cycles it is asserted after data has been accepted at the data bus. Data transfer acknowledge is compatible with the MC68000 and with other Motorola bus masters such as the MC68450 DMA controller. A holding resistor is required to maintain DTACK high between bus cycles.

RESET — Reset Input RESET is a high-impedance input used to initialize all PI/T functions. All control and data direction registers are cleared and most internal operations are disabled by the assertion of RESET (low).

CLK — Clock Input The clock pin is a high-impedance TTL-compatible signal with the same specifications as the MC68000 The PI/T contains dynamic logic throughout, and hence this clock must not be gated off at any time. It is not necessary that this clock maintain any particular phase relationship with the MC68000 clock. It may be connected to an independent frequency source (faster or slower) as long as all bus specifications are met.

PA0-PA7 and PB0-PB7 — Port A and Port B Ports A and B are 8-bit ports that may be concatenated to form a 16-bit port in certain modes. The ports may be controlled in conjunction with the handshake pins H1-H4 For stabilization during system power-up, Ports A and B have internal pullup resistors to VCC. All port pins are active high

H1-H4 — Handshake pins (I/O depending on the Mode and Submode) Handshake pins H1-H4 are multi-purpose pins that (depending on the operational mode) may provide an interlocked handshake, a pulsed handshake, an interrupt input (independent of data transfers), or simple I/O pins. For stabilization during system power-up, H2 and H4 have internal pullup resistors to V_{CC}. Their sense (active high or low) may be programmed in the Port General Control Register bits 3-0. Independent of the mode, the instantaneous level of the handshake pins can be read from the Port Status Register

Port C — (PCO-PC7/Alternate function) This port can be used as eight general purpose I/O pins (PCO-PC7) or any combination of six special function pins and two general purpose I/O pins (PCO-PC1) (Each dual function pin can be standard I/O or a special function independent of the other port C pins) The dual function pins are defined in the following paragraphs. When used as a port C pin, these pins are active high. They may be individually programmed as inputs or outputs by the Port C Data Direction Register.

The alternate functions (TIN, TOUT, and \overline{TIACK}) are timer I/O pins. TIN may be used as a rising-edge triggered external clock input or an external run/halt control pin (the timer is in the run state if run/halt is high and in the halt state if run/halt is low). TOUT may provide an active low timer interrupt request output or a general-purpose square-wave output, initially high. TIACK is an active low high-impedance input used for timer interrupt acknowledge.

Port A and B functions have an independent pair of active low interrupt request (PIRQ) and interrupt acknowledge (PIACK) pins

The DMAREO (Direct Memory Access Request) pin provides an active low Direct Memory Access Controller (DMAC) request pulse of 3 clock cycles, completely compatible with the MC68450 DMAC

REGISTER MODEL

A register model that includes the corresponding Register Selects is shown in Table 1

| | | egiste lect E | | | TABLE 1 — REGISTER MODEL | | | | | | | | |
|---|---|------------------|---|--------|--------------------------|--------------------|-------------|---------------|-----------|---------------|--------------------------|-----------------|------------------------------------|
| 5 | 4 | 3 | 2 | 1 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | |
| 0 | 0 | 0 | 0 | 0 | Port I | Mode | H34 | H12 | H4 | НЗ | H2 | H1 | Port General |
| Ů | • | · | · | Ü | Con | | Enable | Enable | | Sense | Sense | Sense | Control Register |
| 0 | 0 | 0 | 0 | 1 | * | | CRQ lect | Inter Pf | | | ort Interru ority Con | ' 1 | Port Service Request Register |
| 0 | 0 | 0 | 1 | 0 | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | Port A Data Direction Register |
| 0 | 0 | 0 | 1 | 1 | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | Port B Data Direction Register |
| 0 | 0 | 1 | 0 | 0 | Bit | Bit | Bit | Bit | Bit | Bit | Bit | Bit | Port C Data Direction Register |
| 0 | 0 | 1 | 0 | 1 | 7 | 6 Inte | rrupt Ve | 4 ctor Nun | 3 nbet | 2 | * | 0 * | Port Interrupt Vector Register |
| | | | | | | 2111 | | | | H2 | H1 | H1 | = |
| 0 | 0 | 1 | 1 | 0 | Por Subr | | - | 12 Contro | ol | Int Enable | SVCRQ Enable | Stat Ctrl | Port A Control Register |
| | | | | | 3001 | noue | ļ | | | H4 | НЗ | H3 | o . |
| 0 | 0 | 1 | 1 | 1 | Por | t B | ⊦ | 4 Contro | ol | Int | SVCRQ | Stat | Port B Control Register |
| - | - | - | - | · | Subr | | | | | Enable | Enable | Ctrl | riegister |
| 0 | 1 | 0 | 0 | 0 | Bit | Bit | Bit | Bit | Bit | Bit | Bit | Bit | Port A Data |
| U | | Ü | U | U | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | Register |
| 0 | 1 | 0 | 0 | 1 | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | Port B Data Register |
| 0 | 1 | 0 | 1 | 0 | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | Port A Alternate Register |
| 0 | 1 | 0 | 1 | 1 | Bit | Bit | Bit | Bit | Bit | Bit | Bit | Bit | Port B Alternate Register |
| 0 | 1 | 1 | 0 | 0 | 7 Bit | 6 Bit | 5 Bit | 4 Bit | 3 Bit | 2 Bit | 1 Bit | 0 Bit | Port C Data Register |
| | | | _ | | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | Port Status |
| 0 | 1 | 1 | 0 | 1 | H4 Level | H3 Level | H2 Level | H1 Level | H4S | H3S | H2S | H1S | Register |
| 0 | 1 | 1 | 1 | 0 | * | * | * | * | * | * | * | * | (null) |
| 0 | 1 | 1 | 1 | 1 | * | * | * | * | * | * | * | * | (null) |
| 1 | 0 | 0 | 0 | 0 | | OUT/TIA Control | | Z D Ctrl | * | Co | ock ntrol | Timer Enable | Timer Control Register |
| 1 | 0 | 0 | 0 | 1 | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | Timer Interrupt Vector Register |
| 1 | 0 | 0 | 1 | 0 | * | * | * | * | * | * | * | * | (null) |
| 1 | 0 | 0 | 1 | 1 | Bit 23 | Bit 22 | Bit 21 | Bit 20 | Bit 19 | Bit 18 | Bit 17 | Bit 16 | Counter Preload Register (High) |
| 1 | 0 | 1 | 0 | 0 | Bit 15 | Bit 14 | Bit 13 | Bit 12 | Bit 11 | Bit 10 | Bit 9 | Bit 8 | (Mid) |
| 1 | 0 | 1 | 0 | 1 | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | (Low) |
| 1 | 0 | 1 | 1 | 0 | * | * | * | * | * | * | * | * | (null) |
| | • | | | | Bit | Bit | Bit | Bit | Bit | Bit | Bit | Bit | Count Register |
| 1 | 0 | 1 | 1 | 1 | 23 Bit | 22 Bit | 21 Bit | 20 Bit | 19 Bit | 18 Bit | 17 Bit | 16 Bit | (High) |
| 1 | 1 | 0 | 0 | 0 | 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | (Mid) |
| 1 | 1 | 0 | 0 | 1 | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | (Low) |
| 1 | 1 | 0 | 1 | 0 | * | * | * | * | * | * | * | ZDS | Timer Status Register |
| 1 | 1 | 0 | 1 | 1 | * | * | * | * | * | * | * | * | (null) |
| 1 | 1 | 1 | 0 | 0 | * | * | * | * | * | * | * | * | (null) |
| 1 | 1 | 1 | 0 | 1 | * | * | * | * | * | * | * | * | (null) |
| 1 | 1 | 1 | 1 | 0 1 | * | * | * | * | * | * | * | * | (null) |
| 1 | 1 | 1 | ' | 1 | * | * | * | * | * | * | * | * | (null) |

^{*}Unused, read as zero

PORT CONTROL STRUCTURE

The primary focus of most applications will be on Ports A and B, the handshake pins, the port interrupt pins, and the DMA request pin. They are controlled in the following way, the Port General Control Register contains a 2-bit field that specifies a set of four operation modes. These govern the overall operation of the ports and determine their interrelationships. Some modes require additional information from each port's control register to further define its operation. In each port control register, there is a 2-bit submode field that serves this purpose. Each port mode/submode combination specifies a set of programmable characteristics that fully define the behavior of that port and two of the handshake pins. This structure is summarized in Table 2 and Figure 10.

FIGURE 10 - PORT MODE LAYOUT

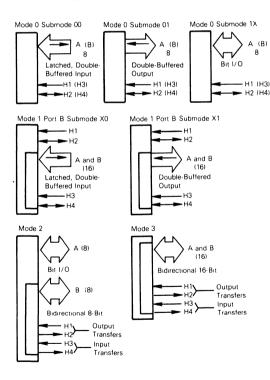


TABLE 2 - PORT MODE CONTROL SUMMARY

Mode 0 (Unidirectional 8-Bit Mode)

Port A

Submode 00 - Double-Buffered Input

· H1 - Latches input data

H2 – Status/interrupt generating input, general-purpose output, or operation with H1 in the interlocked or pulsed input handshake protocols

Submode 01 - Double-Buffered Output

H1 - Indicates data received by peripheral

 H2 – Status/interrupt generating input, general-purpose output, or operation with H1 in the interlocked or pulsed output handshake protocols

Submode 1X - Bit I/O

H1 - Status/interrupt generating input

H2 — Status/interrupt generating input or general-purpose output

Port B, H3 and H4 - Identical to Port A, H1 and H2

Mode 1 (Unidirectional 16-Bit Mode)

Port A — Double-Buffered Data (Most significant) Submode XX (not used)

H1 - Status/interrupt generating input

H2 – Status/interrupt generating input or general-purpose output

Port B - Double-Buffered Data (Least significant)

Submode X0 - Unidirectional 16-Bit Input

H3 - Latches input data

H4 – Status/interrupt generating input, general-purpose output, or operation with H3 in the interlocked or pulsed input handshake protocols

Submode X1 - Unidirectional 16-Bit Output

H3 - Indicates data received by peripheral

H4 — Status/interrupt generating input, general-purpose output, or operation with H3 in the interlocked or pulsed output handshake protocols

Mode 2 (Bidirectional 8-Bit Mode)

Port A - Bit I/O (with no handshaking pins)

Submode XX (not used)

Port B - Bidirectional 8-Bit Data (Double-Buffered)

ort B — Bidirectional 8-Bi Submode XX (not used)

H1 - Indicates output data received by peripheral

H2 — Operation with H1 in the interlocked or pulsed output handshake protocols

H3 - Latches input data

H4 — Operation with H3 in the interlocked or pulsed input handshake protocols

Mode 3 (Bidirectional 16-Bit Mode)

Port A — Double-Buffered Data (Most significant)
Submode XX (not used)

Port B — Double-Buffered Data (Least significant)

Submode XX (not used)
H1 — Indicates output data received by peripheral

H2 — Operation with H1 in the interlocked or pulsed output handshake protocols

H3 - Latches input data

H4 — Operation with H3 in the interlocked or pulsed input handshake protocols

PORT GENERAL INFORMATION AND CONVENTIONS

The following paragraphs introduce concepts that are generally applicable to the PI/T ports independent of the chosen mode and submode. For this reason, no particular port or handshake pins are mentioned, the notation H1 (H3) indicates that, depending on the chosen mode and submode, the statement given may be true for either the H1 or H3 handshake pin.

Unidirectional vs Bidirectional — Figure 10 shows the configuration of Ports A and B and each of the handshake pins in each port mode and submode. In Modes 0 and 1, a data direction register is associated with each of the ports. These registers contain one bit for each port pin to determine whether that pin is an input or an output. Modes 0 and 1 are, thus, called unidirectional modes because each pin assumes a constant direction, changeable only by a reset condition or a programming change. These modes allow double-buffered data transfers in one direction. This direction, determined by the mode and submode definition, is known as the primary direction. Data transfers in the primary direction are controlled by the handshake pins. Data transfers not in the primary direction are generally unrelated, and single or unbuffered data paths exist.

In Modes 2 and 3 there is no concept of primary direction as in Modes 0 and 1. Except for Port A in Mode 2 (Bit I/O), the data direction registers have no effect. These modes are bidirectional, in that the direction of each transfer (always 8 or 16 bits, double-buffered) is determined dynamically by the state of the handshake pins. Thus, for example, data may be transferred out of the ports, followed very shortly by a transfer into the same port pins. Transfers to and from the ports are independent and may occur in any sequence. Since the instantaneous direction is always determined by the external system, a small amount of arbitration logic may be required.

Control of Double-Buffered Data Paths — Generally speaking, the PI/T is a double-buffered device. In the primary direction, double-buffering allows orderly transfers by using the handshake pins in any of several programmable protocols. (When Bit I/O is used, double-buffering is not available and the handshake pins are used as outputs or status/interrupt inputs.)

Use of double-buffering is most beneficial in situations where a peripheral device and the computer system are capable of transferring data at roughly the same speed Double-buffering allows the fetch operation of the data transmitter to be overlapped with the store operation of the data receiver. Thus, throughput measured in bytes or wordsper-second may be greatly enhanced. If there is a large mismatch in transfer capability between the computer and the peripheral, little or no benefit is obtained. In these cases there is no penalty in using double-buffering

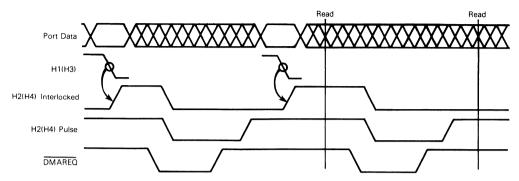
Double-Buffered Input Transfers — In all modes, the PI/T supports double-buffered input transfers. Data that meets the port setup and hold times is latched on the asserted edge

of H1(H3) H1(H3) is edge-sensitive, and may assume any duty-cycle as long as both high and low minimum times are observed. The PI/T contains a Port Status Register whose H1S(H3S) status bit is set anytime any input data is present in the double-buffered latches that has not been read by the bus master. The action of H2(H4) is programmable, it may indicate whether there is room for more data in the PI/T latches or it may serve other purposes. The following options are available, depending on the mode.

- 1 H2(H4) may be an edge-sensitive input that is independent of H1(H3) and the transfer of port data. On the asserted edge of H2(H4), the H2S(H4S) status bit is set it is cleared by the direct method (refer to Direct Method of Resetting Status), the RESET pin being asserted, or when the H12 Enable (H34 Enable) bit of the Port General Control Register is 0.
- 2 H2(H4) may be a general purpose output pin that is always negated The H2S(H4S) status bit is always 0.
- 3 H2(H4) may be a general purpose output pin that is always asserted. The H2S(H4S) status bit is always.
- 4 H2(H4) may be an output pin in the interlocked input handshake protocol. It is asserted when the port input latches are ready to accept new data. It is negated asynchronously following the asserted edge of the H1(H3) input. As soon as the input latches become ready, H2(H4) is again asserted. When the input double-buffered latches are full, H2(H4) remains negated until data is removed. Thus, anytime the H2(H4) output is asserted, new input data may be entered by asserting H1(H3). At other times transitions on H1(H3) are ignored. The H2S(H4S) status bit is always 0. When H12 Enable (H34 Enable) is 0, H2(H4) is held negated.
- 5 H2(H4) may be an output pin in the pulsed input handshake protocol. It is asserted exactly as in the interlocked iliput protocol, but never remains asserted longer than 4 clock cycles. Typically, a four clock cycle pulse is generated. But in the case that a subsequent H1(H3) asserted edge occurs before termination of the pulse, H2(H4) is negated asynchronously. Thus, anytime after the leading edge of the H2(H4) pulse, new data may be entered in the PI/T double-buffered input latches. The H2S(H4S) status bit is always 0. When H12 Enable (H34 Enable) is 0, H2(H4) is held negated.

A sample timing diagram is shown in Figure 11. The H2(H4) interlocked and pulsed input handshake protocols are shown. The DMAREQ pin is also shown: assuming it is enabled. All handshake pin sense bits are assumed to be 0 (refer to Port General Control Register), thus, the pins are in the low state when asserted. Due to the great similarity between modes, this timing diagram is applicable to all double-buffered input transfers.

FIGURE 11 - DOUBLE-BUFFERED INPUT TRANSFERS



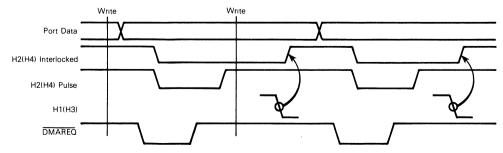
Double-Buffered Output Transfers - The PI/T supports double-buffered output transfers in all modes. Data, written by the bus master to the PI/T, is stored in the port's output latch The peripheral accepts the data by asserting H1(H3), which causes the next data to be moved to the port's output latch as soon as it is available. The function of H2(H4) is programmable, it may indicate whether new data has been moved to the output latch or it may serve other purposes. The H1S(H3S) status bit may be programmed for two interpretations Normally the status bit is a 1 when there is at least one latch in the double-buffered data path that can accept new data After writing one byte/word of data to the ports, an interrupt service routine could check this bit to determine if it could store another byte/word, thus, filling both latches When the bus master is finished, it is often useful to be able to check whether all of the data has been transferred to the peripheral The H1S(H3S) Status Control bit of the Port A and B Control Registers provide this flexibility. The programmable options of the H2(H4) pin are given below, depending on the mode

- 1 H2(H4) may be an edge-sensitive input pin independent of H1(H3) and the transfer of port data. On the asserted edge of H2(H4), the H2S(H4S) status bit is set. It is reset by the direct method (refer to Direct Method of Resetting Status), the RESET pin being asserted, or when the H12 Enable (H34 Enable) bit of the Port General Control Register is 0.
- 2 H2(H4) may be a general-purpose output pin that is always negated The H2S(H4S) status bit is always 0
- 3 H2(H4) may be a general-purpose output pin that is always asserted. The H2S(H4S) status bit is always

- 4 H2(H4) may be an output pin in the interlocked output handshake protocol H2(H4) is asserted two clock cycles after data is transferred to the double-buffered output latches. The data remains stable and H2(H4) remains asserted until the next asserted edge of the H1(H3) input. At that time, H2(H4) is asynchronously negated. As soon as the next data is available, it is transferred to the output latches. When H2(H4) is negated, asserted transitions on H1(H3) have no effect on the data paths. As is explained later, however, in Modes 2 and 3 they do control the three-state output buffers of the bidirectional port(s). The H2S(H4S) status bit is always 0. When H12 Enable (H34 Enable) is 0, H2(H4) is held negated.
- 5 H2(H4) may be an output pin in the pulsed output handshake protocol. It is asserted exactly as in the interlocked output protocol above, but never remains asserted longer than four clock cycles. Typically, a four clock pulse is generated. But in the case that a subsequent H1(H3) asserted edge occurs before termination of the pulse, H2(H4) is negated asynchronously shortening the pulse. The H2S(H4S) status bit is always 0. When H12 Enable (H34 Enable) is 0. H2(H4) is held negated.

A sample timing diagram is shown in Figure 12. The H2(H4) interlocked and pulsed output handshake protocols are shown. The $\overline{\rm DMAREO}$ pin is also shown assuming it is enabled. All handshake pin sense bits are assumed to be 0, thus, the pins are in the low state when asserted. Due to the great similarity between modes, this timing diagram is applicable to all double-buffered output transfer.

FIGURE 12 — DOUBLE-BUFFERED OUTPUT TRANSFERS



Requesting Bus Master Service — The PI/T has several means of indicating a need for service by a bus master. First, the processor may poll the Port Status Register. It contains status bit for each handshake pin, plus a level bit that always reflects the instantaneous state of that handshake pin. A status bit is 1 when the PI/T needs servicing, i.e., generally when the bus master needs to read or write data to the ports, or when a handshake pin used as a simple status input has been asserted. The interpretation of these bits is dependent on the chosen mode and submode.

Second, the PI/T may be placed in the processor's interrupt structure. As mentioned previously, the PI/T contains Port A and B Control Registers that configure the handshake pins. Other bits in these registers enable an interrupt associated with each handshake pin. This interrupt is made available through the PC5/PIRQ pin, if the PIRQ function is selected. Three additional conditions are required for PIRQ to be asserted. (1) the handshake pin status bit set, (2) the corresponding interrupt (service request) enable bit is set, (3) and DMA requests are not associated with that data transfer (H1 and H3 only). The conditions from each of the four handshake pins and corresponding status bits are ORed to determine PIRQ.

The third method of requesting service is via the PC4/DMAREQ pin This pin can be associated with double-buffered transfers in each mode. If it is used as a DMA controller request, it can initiate requests to keep the PI/T's input/output double-buffering empty/full as much as possi-

ble It will not overrun the DMA controller. The pin is compatible with the MC68450 Direct Memory Access Controller (DMAC)

Vectored, Prioritized Port Interrupts — Use of MC68000-compatible vectored interrupts with the PI/T requires the PIRQ and PIACK pins. When PIACK is asserted, the PI/T places an 8-bit vector on the data pins D0-D7. Under normal conditions, this vector corresponds to highest priority, enabled, active port interrupt source with which the $\overline{\text{DMAREQ}}$ pin is not currently associated. The most-significant six bits are provided by the Port Interrupt Vector Register (PIVR), with the lower two bits supplied by prioritization logic according to conditions present when PIACK is asserted. It is important to note that the only affect on the PI/T caused by interrupt acknowledge cycles is that the vector is placed on the data bus. Specifically, no registers, data, status, or other internal states of the PI/T are affected by the cycle.

Several conditions may be present when the \overline{PIACK} input is asserted to the PI/T These conditions affect the PI/T's response and the termination of the bus cycle. If the PI/T will has no interrupt function selected, or is not asserting \overline{PIRQ} , the PI/T will make no response to \overline{PIACK} (\overline{DTACK} will not be asserted). If the PI/T is asserting \overline{PIRQ} when \overline{PIACK} is received, the PI/T will output the contents of the POTI interrupt Vector Register and the prioritization bits. If the PI/T has not been initialized, \$0F will be read from this register. These conditions are summarized in Table 3.

TABLE 3 - RESPONSE TO PORT INTERRUPT ACKNOWLEDGE

| Conditions | PIRQ negated OR interrupt request function not selected | PIRQ asserted |
|---|---|--|
| PIVR has not been initialized since RESET | No response from PI/T No DTACK | PI/T provides \$0F, the Uninitialized Vector • |
| PIVR has been initialized since RESET | No response from PI/T No DTACK | PI/T provides PIVR contents with prioritization bits |

^{*}The uninitialized vector is the value returned from an interrupt vector register before it has been initialized

The vector table entries for the PI/T appear as a contiguous block of four vector numbers whose common upper six bits are programmed in the PIVR. The following table pairs each interrupt source with the 2-bit value provided by the prioritization logic, when interrupt acknowledge is asserted.

H1 source - 00

H2 source - 01

H3 source - 10

H4 source - 11

Autovectored Port Interrupts — Autovecored interrupts use only the \overline{PIRQ} pin. The operation of the PI/T with vectored and autovectored interrupts is identical except that no vectors are supplied and the PC6/ \overline{PIACK} pin can be used as a Port C pin.

Direct Method of Resetting Status — In certain modes one or more handshake pins can be used as edge-sensitive inputs for sole purpose of setting bits in the Port Status Register These bits consist of simple flip-flops. They are set (to 1) by the occurrence of the asserted edge of the hand-

shake pin input. Resetting a handshake status bit can be done by writing an 8-bit mask to the Port Status Register. This is called the direct method of resetting. To reset a status bit that is resettable by the direct method, the mask must contain a 1 in the bit position of the Port Status Register corresponding to the desired bit. Other positions must contain 0's. For status bits that are not resettable by the direct method in the chosen mode, the data written to the port status register has no effect. For status bits that are resettable by the direct method in the chosen mode, a 0 in the mask has no effect.

Handshake Pin Sense Control — The PI/T contains exclusive-OR gates to control the sense of each of the handshake pins, whether used as inputs or outputs. Four bits in the Port General Control Register may be programmed to determine whether the pins are asserted in the low or high voltage state. As with other control registers, these bits are reset to 0 when the RESET pin is asserted, defaulting the asserted level to be low.

Enabling Ports A and B — Certain functions involved with double-buffered data transfers, the handshake pins, and the status bits, may be disabled by the external system or by the

programmer during initialization. The Port General Control Register contains two bits, H12 Enable and H34 Enable, which control these functions. These bits are cleared to the o state when the RESET pin is asserted, and the functions are disabled. The functions are the following.

- 1 Independent of other actions by the bus master or peripheral (via the handshake pins), the PI/T's disabled handshake controller is held to the "empty" state, i e, no data is present in the double-buffered data path
- 2 When any handshake pin is used to set a simple status flip-flop, unrelated to double-buffered transfers, these flip-flops are held reset to 0 (See Table 2)
- 3 When H2(H4) is used in an interlocked or pulsed handshake with H1(H3), H2(H4) is held negated, regardless of the chosen mode, submode, and primary direction Thus, for double-buffered input transfers, the programmer may signal a peripheral when the PI/T is ready to begin transfers by setting the associated handshake enable bit to 1

The Port A and B Alternate Registers — In addition to the Port A and B Data Registers, the PI/T contains Port A and B Alternate Registers These registers are read-only, and simply provide the instantaneous level of each port pin They have no effect on the operation of the handshake pins, double-buffered transfers, status bits, or any other aspect of the PI/T, and they are mode/submode independent

PORT MODES

This section contains information that distinguishes the various port modes and submodes. General characteristics, common to all modes, have been defined previously

MODE 0 - UNIDIRECTIONAL 8-BIT MODE

In Mode 0, Ports A and B operate independently Each may be configured in any of its three possible submodes

Submode 00 — Double-Buffered Input

Submode 01 - Double-Buffered Output

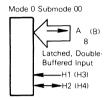
Submode 1X - Bit I/O

Handshake pins H1 and H2 are associated with Port A and configured by programming the Port A Control Register (The H12 Enable bit of the Port General Control Register enables Port A transfers) Handshake pins H3 and H4 are associated with Port B and configured by programming the Port B Control Register (The H34 Enable bit of the Port General Control Register enables Port B transfers) The Port A and B Data Direction Registers operate in all three submodes Along with the submode, they affect the data read and written at the associated data register according to Table 4. They also enable the output buffer associated with each port pin The DMAREQ pin may be associated with either (not both) Port A or Port B, but does not function if the Bit I/O submode is programmed for the chosen port.

TABLE 4 - MODE 0 PORT DATA PATHS

| Mode | | Port A/B Register | Write Port A/B Data Register | | | | | | | | |
|---|---|----------------------|------------------------------|--------------|--|--|--|--|--|--|--|
| | DDR = 0 | DDR = 1 | DDR=X | | | | | | | | |
| 0 Submode 00 | FIL, D B | FOL Note 3 | FOL, S B | Note 1 | | | | | | | |
| 0 Submode 01 | Pın | FOL Note 3 | IOL/FOL, D B | Note 2 | | | | | | | |
| 0 Submode 1X | Pın | FOL Note 3 | FOL, S B | Note 1 | | | | | | | |
| Abbreviations IOL | | | | | | | | | | | |
| single buffer | Note 1 Data is latched in the output data registers (final output latch) and will be single buffered at the pin if the DDR is 1. The output buffers will be turned off if the DDR is 0. | | | | | | | | | | |
| Note 2 Data is latched in the double-buffered output data registers. The data in the final output latch will appear on the port pin if the DDR is a 1 | | | | | | | | | | | |
| Note 3 The output of | rivers that co | nnect the final out | put latch to the pin | s are turned | | | | | | | |

Port A or B Submode 00 (8-Bit Double-Buffered Input) -

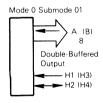


In Mode 0, double-buffered input transfers of up to 8-bits are available by programming Submode 00 in the desired port's control register. The operation of H2 and H4 may be selected by programming the Port A and Port B Control Registers, respectively. All five double-buffered input handshake options, previously mentioned in the Port General Information and Conventions section, are available.

For pins used as outputs, the data path consists of a single latch driving the output buffer. Data written to the port's data register does not affect the operation of any handshake pin, status bit, or any other aspect of the PI/T. Output pins may be used independently of the input transfer. However, read bus cycles to the data register do remove data from the port. Therefore, care should be taken to avoid processor instructions that perform unwanted read cycles.

Refer to PARALLEL PORTS Double-Buffered Input Transfers for a sample timing diagram (Figure 11)

Port A or B Submode 01 (8-Bit Double-Buffered Output) —

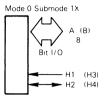


In Mode 0, double-buffered output transfers of up to 8 bits are available by programming submode 01 in the desired port's control register. The operation of H2 and H4 may be selected by programming the Port A and Port B Control Registers, respectively. All five double-buffered output handshake options, previously mentioned in the Port General Information and Conventions section, are available.

For pins used as inputs, data written to the associated data register is double-buffered and passed to the initial or final output latch, as usual, but the output buffer is disabled

Refer to PARALLEL PORTS Double-Buffered Output Transfers for a sample timing diagram (Figure 12)

Port A or B Submode 1X (Bit I/O) -



In Mode 0, simple Bit I/O is available by programming Submode 1X in the desired port's control register. This submode is intended for applications in which several independent devices must be controlled or monitored. Data written to the associated data register is single-buffered. If the data direction register bit for that pin is a 1 (output), the output buffer is enabled. If it is 0 (input), data written is still latched, but is not available at the pin. Data read from the data register is the instantaneous value of the pin or what was written to the data register, depending on the contents of the data direction register. H1(H3) is an edge-sensitive status input pin only and it controls no data-related function. The H1S(H3S) status bit is set following the asserted edge of the input waveform. It is reset by the direct method, the RESET pin being asserted, or when the H12 Enable (H34 Enable) bit is 0.

H2(H4) can be programmed as a simple status input (identical to H1(H3)), or as an asserted or negated output. The interlocked or pulsed handshake configurations are not available.

MODE 1 - UNIDIRECTIONAL 16-BIT MODE

In Mode 1, Ports A and B are concatenated to form a single 16-bit port. The Port B Submode field controls the configuration of both ports. The possible submodes are

Port B Submode X0 — Double-Buffered Input Port B Submode X1 — Double-Buffered Output

Handshake pins H3 and H4, configured by programming the Port B Control Register, are associated with the 16-bit double-buffered transfer. These 16-bit transfers, are enabled by the H34 Enable bit of the Port General Control Register Handshake pins H1 and H2 may be used as simple status inputs not related to the 16-bit data transfer or H2 may be an output. Enabling of the H1 and H2 handshake pins is done by the H12 Enable bit of the Port General Control Register. The Port A and B Data Direction Registers operate in each submode. Along with the submode, they affect the data read and written at the data register according to Table 5. They also enable the output buffer associated with each port pin The DMAREQ pin may be associated only with H3.

Mode 1 can provide convenient, high-speed 16-bit transfers. The Port A and B data registers are addressed for compatibility with the MC68000 Move Peripheral (MOVEP) instruction and with the MC68450 DMAC. To take advantage of this, Port A should contain the most-significant byte of data and always be read or written by the bus master first. The interlocked and pulsed handshake protocols are keyed to accesses to the Port B Data Register in Mode 1. If it is accessed last, the 16-bit double-buffered transfers proceed smoothly.

Read Port A/B Write Port A/B Mode Register Register DDR = 0 DDR = 1 DDR = 0 DDR = 1 1, Port B FIL, D B FOL FOL, S B FOL, S B Submode X0 Note 3 Note 2 Note 2 IOL/FOL. 1 Port B Pın FOL IOL/FOL DB, Submode X1 Note 3 DB, Note 1 Note 1 Note 1 Data written to Port A goes to a temporary latch When the Port B data register is later written, Port A data is transferred to IOL/FOL Note 2 Data is latched in the output data registers (final output latch) and will be single buffered at the pin if the DDR is 1. The output buffers will be turned off if the DDR is 0 Note 3 The output drivers that connect the final output latch to the pins are turned

S B - Single Buffered

D.B. - Double Buffered

DDR - Data Direction Register

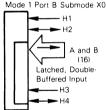
TABLE 5 - MODE 1 PORT DATA PATHS

Port B Submode X0 (16-Bit Double-Buffered Input) -

Abbreviations IOL - Initial Output Latch

FOL - Final Output Latch

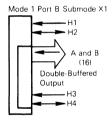
FIL - Final Input Latch



In Mode 1 Port B Submode X0, double-buffered input transfers of up to 16 bits may be obtained. The level of all 16 pins is asynchronously latched with the asserted edge of H3 The processor may check H3S status bit to determine if new data is present. The DMAREQ pin may be used to signal a DMA controller to empty the input buffers Regardless of the bus master, Port A data should be read first (Actually, Port A data need not be read at all) Port B data should be read last. The operation of the internal handshake controller, the H3S bit, and DMAREQ are keyed to the reading of the Port B data register (The MC68450 DMAC can be programmed to perform the exact transfers needed for compatibility with the PI/T) H4 may be programmed for all five of the handshake options mentioned in the Port General Information and Conventions section.

For pins used as outputs, the data path consists of a single latch driving the output buffer Data written to the port's data register does not affect the operation of any handshake pin, status bit, or any other aspect of the PI/T Thus, output pins may be used independently of the input transfer However, read bus cycles to the Port B Data Register do remove data, so care should be taken to avoid unwanted read cycles

Port B Submode X1 (16-Bit Double-Buffered Output) -



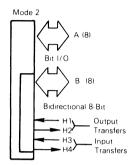
Refer to PARALLEL PORTS Double-Buffered Input Transfers for a sample timing diagram (Figure 11)

In Mode 1 Port B Submode X1, double-buffered output transfers of up to 16 bits may be obtained. Data is written by the bus master (processor or DMA controller) in two bytes The first byte (most-significant) is written to the Port A Data Register It is stored in a temporary latch until the next byte is written to the Port B Data Register. Then all 16 bits are transferred to the final output latches of Ports A and B Both options for interpretation of the H3S status bit, mentioned in Port General Information and Comments section, are available and apply to the 16-bit port as a whole The DMAREQ pin may be used to signal a DMA controller to transfer another word to the port output latches (The MC68450 DMAC can be programmed to perform the exact transfers needed for compatibility with the PI/T) H4 may be programmed for all five of the handshake options mentioned in the Port General Information and Comments section

For pins used as inputs, data written to either data register is double-buffered and passed to the initial or final output latch, as usual, but the output buffer is disabled

Refer to PARALLEL PORTS Double-Buffered Input/Output Transfer for a sample timing diagram (Figure 12)

MODE 2 - BIDIRECTIONAL 8-BIT MODE



In Mode 2. Port A is used for simple bit I/O with no associated handshake pins. Port B is used for bidirectional 8-bit double-buffered transfers H1 and H2, enabled by the H12 Enable bit in the Port General Control Register, control output transfers, while H3 and H4, enabled by the Port General Control Register bit H34 Enable, control input transfers. The instantaneous direction of the data is determined by the H1 handshake pin. The Port B Data Direction Register is not used. The Port A and Port B submode fields. do not affect PI/T operation in Mode 2

Double-Buffered I/O (Port B) - The only aspect of bidirectional double-buffered transfers that differs from the unidirectional modes lies in controlling the Port B output buf-

fers They are controlled by the level of H1 When H1 is negated, the Port B output buffers (all 8) are enabled and the pins drive the bidirectional bus. Generally, H1 is negated in response to an asserted H2, which indicates that new output data is present in the double-buffered latches. Following acceptance of the data, the peripheral asserts H1, disabling the Port B output buffers Other than controlling the output buffer, H1 is edge-sensitive as in other modes. Input transfers proceed identically to the double-buffered input protocol described in the Port General Information and Conventions Section. In Mode 2, only the interlocked and pulsed handshake pin options are available on H2 and H4 The DMAREQ pin may be associated with either input transfers (H3) or output transfers (H1), but not both Refer to Table 6 for a summary of the Port B Data Register responses in Mode 2

Bit I/O (Port A) — Mode 2, Port A performs simple bit I/O with no associated handshake pins. This configuration is intended for applications in which several independent devices must be controlled or monitored. Data written to the Port A. data register is single-buffered. If the Port A Data Direction Register bit for that pin is 1 (output), the output buffer is enabled If it is 0, data written is still latched but not available at the pin. Data read from the data register is either the instantaneous value of the pin or what was written to the data register, depending on the contents of the Port A Data Direction Register This is summarized in Table 7

TABLE 6 - MODE 2 PORT B DATA PATHS

| Mode | Read Port B Data Register | Write Port B Data Register |
|--|------------------------------|-------------------------------|
| 2 | FIL, D B | IOL/FOL, D B |
| Abbreviations IOL — Initial Output L FOL — Final Output L FIL — Final Input Late | atch DB - | Double Buffered |

TABLE 7 - MODE 2 PORT A DATA PATHS

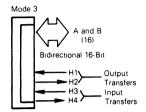
| Mode | | Port A Register | Write Port A Data Register | | |
|---------------|-------|--------------------|-------------------------------|----------|--|
| | DDR=0 | DDR = 1 | DDR=0 | DDR = 1 | |
| 2 | Pin | FOL | FOL | FOL, S B | |
| Abbreviations | | | | | |

S B - Single Buffered

FOL - Final Output Latch

DDR - Data Direction Register

MODE 3 — BIDIRECTIONAL 16-BIT DOUBLE-BUFFERED I/O



In Mode 3, Ports A and B are used for bidirectional 16-bit double-buffered transfers H1 and H2 control output transfers, while H3 and H4 control input transfers (H1 and H2 are enabled by the H12 Enable bit while H3 and H4 are enabled by the H34 Enable bit of the Port General Control Register) The instantaneous direction of the data is determined by the H1 handshake pin, and thus, the data direction registers are not used. The Port A and Port B submode fields do not affect PI/T operation in Mode 3.

The only aspect of bidirectional double-buffered transfers that differs from the unidirectional modes lies in controlling the Port A and B output buffers. They are controlled by the level of H1. When H1 is negated, the output buffers (all 16) are enabled and the pins drive the bidirectional bus. Generally, H1 is negated in response to an asserted H2, which indicates that new output data is present in the double-buffered latches. Following acceptance of the data, the peripheral asserts H1, disabling the output buffers. Other than controlling the output buffers, H1 is edge-sensitive as in

other modes Input transfers proceed identically to the double-buffered input protocol described in the Port General Information and Conventions section [Port A and B data latched with the asserted edge of H3 In Mode 3, only the interlocked and pulsed handshake pin options are available to H2 and H4 The DMAREQ pin may be associated with either input transfers (H3) or output transfers (H1), but not both H2 indicates when new data is available in the Port B (and implicitly Port A) output latches, but unless the buffer is enabled by H1, the data is not driving the pins

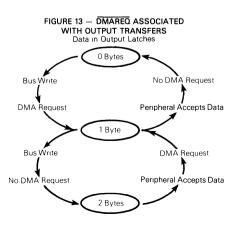
Mode 3 can provide convenient high-speed 16-bit transfers. The Port A and B Data Registers are addressed for compatibility with the MC68000's Move Peripheral (MOVEP) instruction and with the MC68450 DMAC. To take advantage of this, Port A should contain the most-significant data and always be read or written by the bus master first. The interlocked and pulsed handshake protocols are keyed to accesses to the Port B Data Register in Mode 3. If it is accessed last, the 16-bit double-buffered transfer proceed smoothly. Refer to Table 8 for a summary of the Port A and B data paths in Mode 3.

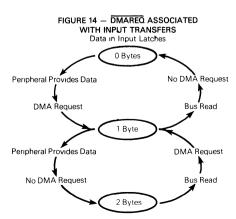
DMA REQUEST OPERATION

The Direct Memory Access Request (DMAREQ) pulse can be associated with output or input transfers to keep the initial and final output latches full or initial and final input latches empty respectively. Figures 13 and 14 show all the possible paths in generating DMA requests

TABLE 8 - MODE 3 PORT A AND B DATA PATHS

| Mode | Read Port A and B Data Register | Write Port A and B Data Register | | | | | | |
|---|------------------------------------|-------------------------------------|--|--|--|--|--|--|
| 3 | FIL, D B | IOL/FOL, D B , Note 1 | | | | | | |
| Note 1 Data written to Port A goes to a temporary latch When the Port B data register is later written, Port A data is transferred to IOL/FOL | | | | | | | | |
| Abbreviations IOL — Initial Output FOL — Final Output FIL — Final Input Le | Latch DB - 1 | Single Buffered Double Buffered | | | | | | |





TIMER

The MC68230 timer can provide several facilities needed by MC68000 operating systems. It can generate periodic interrupts, a square wave, or a single interrupt after a programmed time period. Also, it can be used for elapsed time measurement or as a device watchdog. This section describes the programmable options available, capabilities, and restrictions that apply to the timer.

The PI/T timer contains a 24-bit synchronous down counter that is loaded from three 8-bit Counter Preload Registers. The 24-bit counter may be clocked by the output of a 5-bit (divide-by-32) prescaler or by an external timer input TIN. If the prescaler is used, it may be clocked by the system clock (CLK pin) or by the TIN external input. The counter signals the occurrence of an event primarily through zero detection. (A zero is when the counter of the 24-bit timer is equal to zero.) This sets the zero detect status (ZDS) bit in the Timer Status Register. It may be checked by the processor or may be used to generate a timer interrupt. The ZDS bit is reset by writing a 1 to the Timer Status Register in that bit position.

The general operation of the timer is flexible and easily programmable. The timer is fully configured and controlled by programming the 8-bit Timer Control Register. It controls: (1) the choice between the Port C operation and the timer operation of three timer pins, (2) whether the counter is loaded from the Counter Preload Register or rolls over when zero detect is reach, (3) the clock input, (4) whether the prescaler is used, and (5) whether the timer is enabled.

RUN/HALT DEFINITION

The overall operation of the timer is described in terms of the run or halt states. The control of the current state is determined by programming the Timer Control Register When in the halt state, all of the following occur.

- The prior contents of the counter is not altered and is reliably readable via the Count Registers.
- 2. The prescaler is forced to \$1F whether or not it is used.
- The ZDS status bit is forced to 0, regardless of the possible zero contents of the 24-bit counter.

The run state is characterized by:

- The counter is clocked by the source programmed in the Timer Control Register
- 2. The counter is not reliably readable.
- The prescaler is allowed to decrement if programmed for use.
- The ZDS status bit is set when the 24-bit counter transitions from \$000001 to \$000000.

TIMER RULES

This section provides a set of rules that allow easy application of the timer.

- 1. Refer to the Run/Halt Definition above.
- When the RESET pin is asserted, all bits of the Timer Control Register go to 0, configuring the dual function pins as Port C inputs.
- 3. The contents of the Counter Preload Registers and counter are not affected by the RESET pin
- 4. The Count Registers provide a direct read data path from each portion of the 24-bit counter, but data written to their addresses is ignored. (This results in a normal bus cycle.) These registers are readable at any time, but their contents are never latched. Unreliable data may be read when the timer is in the run state.

- The Counter Preload Registers are readable and writable at any time and this occurs independently of any timer operation. No protection mechanisms are provided against ill-timed writes.
- 6 The input frequency to the 24-bit counter from the TIN pin or prescaler output, must be between 0 and the input frequency at CLK pin divided by 32 regardless of the configuration chosen.
- 7. For configurations in which the prescaler is used (with the CLK pin or TIN pin as an input), the contents of the Counter Preload Register (CPR) is transferred to the counter the first time that the prescaler passes from \$00 to \$1F (rolls over) after entering the run state Thereafter, the counter decrements or is loaded from the Counter Preload Register when the prescaler rolls over.
- For configurations in which the prescaler is not used, the contents of the Counter Preload Registers are transferred to the counter on the first asserted edge of the TIN input after entering the run state. On subsequent asserted edges the counter decrements or is loaded from the Counter Preload Registers.
- The lowest value allowed in the Counter Preload Register for use with the counter is \$000001.

TIMER INTERRUPT ACKNOWLEDGE CYCLES

Several conditions may be present when the timer interrupt acknowledge pin (TĪACR) is asserted. These conditions affect the PI/T's response and the termination of the bus cycle. (See Table 9.)

TABLE 9 — RESPONSE TO TIMER INTERRUPT ACKNOWLEDGE

| PC3/TOUT Function | Response to Asserted TIACK |
|--|--|
| PC3 — Port C Pin | No response No DTACK |
| TOUT — Square Wave | No response No DTACK |
| TOUT — Negated Timer Interrupt Request | No response. No DTACK |
| TOUT - Asserted Timer Interrupt Request | Timer Interrupt Vector Contents DTACK Asserted |

PROGRAMMER'S MODEL

The internal accessible register organization is represented in Table 10. Address space within the address map is reserved for future expansion. Throughout the PI/T data sheet the following conventions are maintained:

- A read from a reserved location in the map results in a read from the "null register." The null register returns all zeros for cata and results in a normal bus cycle. A write to one of these locations results in a normal bus cycle but no write occurs.
- Unused bits of a defined register are denoted by "*" and are read as zeroes.
- Bits that are unused in the chosen mode/submode but are used in others, are denoted by "X", and are readable and writeable. Their content, however, is ignored in the chosen mode/submode.
- 4. All registers are addressable as 8-bit quantities. To facilitate operation with the MOVEP instruction and the DMAC, addresses are ordered such that certain sets of registers may also be accessed as words (2 bytes) or long words (4 bytes).

TABLE 10 - PI/T REGISTER ADDRESSING ASSIGNMENTS

| Register | | Register Select Bits | | | | | Affected by | Affected by Read |
|--|---|-------------------------|---|---|---|------|-------------|---------------------|
| - | 5 | 4 | 3 | 2 | 1 | | Reset | Cycle |
| Port General Control Register (PGCR) | 0 | 0 | 0 | 0 | 0 | RW | Yes | No |
| Port Service Request Register (PSRR) | 0 | 0 | 0 | 0 | 1 | R W | Yes | No |
| Port A Data Direction Register (PADDR) | 0 | 0 | 0 | 1 | 0 | R W | Yes | No |
| Port B Data Direction Register (PBDDR) | 0 | 0 | 0 | 1 | 1 | R W | Yes | No |
| Port C Data Direction Register (PCDDR) | 0 | 0 | 1 | 0 | 0 | R W | Yes | No |
| Port Interrupt Vector Register (PIVR) | 0 | 0 | 1 | 0 | 1 | R W | Yes | No |
| Port A Control Register (PACR) | 0 | 0 | 1 | 1 | 0 | R W | Yes | No |
| Port B Control Register (PBCR) | 0 | 0 | 1 | 1 | 1 | R W | Yes | No |
| Port A Data Register (PADR) | 0 | 1 | 0 | 0 | 0 | R W | No | * * |
| Port B Data Register (PBDR) | 0 | 1 | 0 | 0 | 1 | R W | No | * * |
| Port A Alternate Register (PAAR) | 0 | 1 | 0 | 1 | 0 | R | No | No |
| Port B Alternate Register (PBAR) | 0 | 1 | 0 | 1 | 1 | R | No | No |
| Port C Data Register (PCDR) | 0 | 1 | 1 | 0 | 0 | R W | No | No |
| Port Status Register (PSR) | 0 | 1 | 1 | 0 | 1 | R W* | Yes | No |
| Timer Control Register (TCR) | 1 | 0 | 0 | 0 | 0 | R W | Yes | No |
| Timer Interrupt Vector Register (TIVR) | 1 | 0 | 0 | 0 | 1 | R W | Yes | No |
| Counter Preload Register High (CPRH) | 1 | 0 | 0 | 1 | 1 | R W | No | No |
| Counter Preload Register Middle (CPRM) | 1 | 0 | 1 | 0 | 0 | R W | No | No |
| Counter Preload Register Low (CPRL) | 1 | 0 | 1 | 0 | 1 | R W | No | No |
| Count Register High (CNTRH) | 1 | 0 | 1 | 1 | 1 | R | No | No |
| Count Register Middle (CNTRM) | 1 | 1 | 0 | 0 | 0 | R | No | No |
| Count Register Low (CNTRL) | 1 | 1 | 0 | 0 | 1 | R | No | No |
| Timer Status Register (TSR) | 1 | 1 | 0 | 1 | 0 | R W* | Yes | No |

^{*} A write to this register may perform a special status resetting operation

** Mode dependent

respective operation(s)

R= Read W = Write

Port General Control Register (PGCR) -

| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|---|---|---|-------------|---|---|---|
| Port I Con | | | | H4 Sense | | | |

The Port General Control Register controls many of the functions that are common to the overall operation of the ports The PGCR is composed of three major fields: bits 7 and 6 define the operational mode of Ports A and B and affect operation of the handshake pins and status bits, bits 5 and 4 $\,$ allow a software controlled disabling of particular hardware associated with the handshake pins of each port, and bits 3-0 define the sense of the handshake pins. The PGCR is always readable and writeable

All bits are reset to 0 when the RESET pin is asserted The Port Mode Control field should be altered only when the H12 Enable and H34 Enable bits are 0 Except when Mode 0 is desired, the Port General Control register must be

written once to establish the mode, and again to enable the

PGCR 7 6 Port Mode Control

0 0 Mode 0 (Unidirectional 8-Bit Mode) Mode 1 (Unidirectional 16-Bit Mode) 0 1

1 0 Mode 2 (Bidirectional 8-Bit Mode)

Mode 3 (Bidirectional 16-Bit Mode)

PGCR

<u>5</u> H34 Enable

Disabled

1 Enabled

PGCR

H12 Enable

Disabled Enabled

PGCR

3-0 Handshake Pin Sense

- The associated pin is at the high-voltage level when negated and at the low-voltage level when asserted.
- The associated pin is at the low-voltage level when negated and at the high-voltage level when asserted

Port Service Request Register (PSRR) -

| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---|------------|---|---|-------------|---|----------|---|
| * | SVC Sel | | | rrupt FS | | t Interr | |

The Port Service Request Register controls other functions that are common to the overall operation to the ports. It is composed of four major fields: bit 7 is unused and is always read as 0, bits 6 and 5 define whether interrupt or DMA requests are generated from activity on the H1 and H3 handshake pins, bits 4 and 3 determine whether two dual function pins operate as Port C or port interrupt request/acknowledge pins, and bits 2, 1, and 0 control the priority among all port interrupt sources. Since bits 2, 1, and 0 affect interrupt operation, it is recommended that they be changed only when the affected interrupt(s) is fare) disabled or known to remain inactive. The PSRR is always readable and writeable.

All bits are reset to 0 when the RESET pin is asserted

PSRR

6 5

SVCRQ Select

- 0 X The PC4/DMAREQ pin carries the PC4 function, DMA is not used
- 1 0 The PC4/DMAREQ pin carries the DMAREQ function and is associated with double-buffered transfers controlled by H1. H1 is removed from the PI/T's interrupt structure, and thus, does not cause interrupt requests to be generated. To obtain DMAREQ pulses, Port A Control Register bit 1 (H1 SVCRQ Enable) must be a 1
- 1 1 The PC4/DMAREQ pin carries the DMAREQ function and is associated with double-buffered transfers controlled by H3 H3 is removed from the PI/T's interrupt structure, and thus, does not cause interrupt requests to be generated To obtain DMAREQ pulses, Port B Control Register bit 1 (H3 SVCRQ Enable) must be 1

PSRR

- 4 3 Interrupt Pin Function Select
- 0 0 The PC5/PIRQ pin carries the PC5 function.
 The PC6/PIACK pin carries the PC6 function.
- 0 1 The PC5/PIRQ pin carries the PIRQ function The PC6/PIACK pin carries the PC6 function.
- 1 0 The PC5/PIRQ pin carries the PC5 function The PC6/PIACK pin carries the PIACK function.
- 1 1 The PC5/PIRQ pin carries the PIRQ function.
 The PC6/PIACK pin carries the PIACK function

Bits 2, 1, and 0 determine port interrupt priority. The priority is shown in descending order left to right.

| Ρ | SR | R | Port | Interrupt | Priority | Control |
|---|----|---|--------|-----------|----------|---------|
| 2 | 1 | 0 | Highes | it | | Lowest |
| ō | ō | ō | H1S | H2S | H3S | H4S |
| 0 | 0 | 1 | H2S | H1S | H3S | H4S |
| 0 | 1 | 0 | H1S | H2S | H4S | H3S |
| 0 | 1 | 1 | H2S | H1S | H4S | H3S |
| 1 | 0 | 0 | H3S | H4S | H1S | H2S |
| 1 | 0 | 1 | H3S | H4S | H2S | H1S |
| 1 | 1 | 0 | H4S | H3S | H1S | H2S |
| 1 | 1 | 1 | H4S | H3S | H2S | H1S |

Port A Data Direction Register (PADDR) — The Port A Data Direction Register determines the direction and buffering characteristics of each of the Port A pins. One bit in the PADDR is assigned to each pin. A 0 indicates that the pin is used as an input, while a 1 indicates it is used as an output. The PADDR is always readable and writeable. This register is ignored in Mode 3.

All bits are reset to the 0 (input) state when the RESET pin is asserted

Port B Data Direction Register (PBDDR) — The PBDDR is identical to the PADDR for the Port B pins and the Port B Data Register, except that this register is ignored in Modes 2 and 3

Port C Data Direction Register (PCDDR) — The Port C Data Direction Register specifies whether each dual-function pin that is chosen for Port C operation is an input (0) or an output (1) pin The PCDDR, along with bits that determine the respective pin's function, also specify the exact hardware to be accessed at the Port C Data Register address (See the Port C Data Register description for more details) The PCDDR is an 8-bit register that is readable and writeable at all times. Its operation is independent of the chosen PI/T mode

These bits are cleared to 0 when the RESET pin is asserted

Port Interrupt Vector Register (PIVR) -

| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---|--------|--------|--------|-------|---|---|---|
| | Interr | upt Ve | ctor N | umber | | * | * |

The Port Interrupt Vector Register contains the upper order six bits of the four port interrupt vectors. The contents of this register may be read two ways, by an ordinary read cycle, or by a port interrupt acknowledge bus cycle. The exact data read depends on how the cycle was initiated and other factors. Behavior during a port interrupt acknowledge cycle is summarized above in Table 3.

From a normal read cycle (CS), there is never a consequence to reading this register. Following negation of the RESET pin, but prior to writing to the PIVR, a \$0F will be read. After writing to the register, the upper 6 bits may be read and the lower 2 bits are forced to 0. No prioritization computation is performed.

Port A Control Register (PACR) -

| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------|---|---|---------|----|---|-----------------------|---|
| Por Subn | | н | 2 Contr | ol | | H1 SVCRQ Enable | |

The Port A Control Register, in conjunction with the programmed mode and the Port B submode, control the operation of Port A and the handshake pins H1 and H2. The Port A Control Register contains five fields: bits 7 and 6 specify the Port A submode, bits 5, 4, and 3 control the operation of the H2 handshake pin and H2S status bit, bit 2 determines whether an interrupt will be generated when the H2S status bit goes to 1, bit 1 determines whether a service request (interrupt request or DMA request) will occur; bit 0 controls the operation of the H1S status bit. The PACR is always readable and writeable

All bits are cleared to 0 when the RESET pin is asserted. When the Port A submode field is relevant in a mode/submode definition, it must not be altered unless the H12 Enable bit in the Port General Control Register is 0 (See Table 2.)

The operation of H1 and H2 and their related status bits is given below, for each of the modes specified by Port General Control Register bits 7 and 6. This description is organized such that for each mode/submode all programmable options of each pin and status bit are given

Bits 2 and 1 carry the same meaning in each mode/submode, and thus are specified only once

PACR

| ~01 | • | | | |
|-----|------------------|------|-----------|--------|
| 2 | | H2 | Interrupt | Enable |
| 0 | The H2 interrupt | IS (| disabled. | |

1 The H2 interrupt is enabled.

PACR

| 1 | ⊔1 | SVCRQ Enable |
|---|----|--------------|
| | | |

- 0 The H1 interrupt and DMA request are disabled.
- 1 The H1 interrupt and DMA request are enabled

PACR Mode 0 Port A Submode 00

PACR 5 4 3

H2 Control

0 X X Input pin - status only.

1 0 0 Output pin - always negated.

1 0 1 Output pin - always asserted.

1 1 0 Output pin — interlocked input handshake pro-

1 1 1 Output pin - pulsed input handshake protocol.

PACR

<u>0</u>

H1 Status Control

PACR Mode 0 Port a Submode 01

PACR

5 4 3 H2 Control

0 X X Input pin — status only. 1 0 0 Output pin — always negated.

1 0 1 Output pin — always asserted.

0 1 Output pin — always asserted.
 1 0 Output pin — interlocked output handshake pro-

tocol.

1 1 1 Output pin - pulsed output handshake protocol

PACR

H1 Status Control

The H1S status bit is 1 when either the Port A initial or final output latch can accept new data. It is 0 when both latches are full and cannot accept new data.

1 The H1S status bit is 1 when both of the Port A output latches are empty. It is 0 when at least one latch is full.

PACR Mode 0 Port A Submode 1X

PCR

| 5 | 4 | 3 H2 Contro |
|---|---|-------------------------------|
| 0 | X | X Input pin - status only. |
| 1 | v | O Output pip - always pogator |

1 X 0 Output pin - always negated.
1 X 1 Output pin - always asserted.

040

PACR 0 H1 Status Control X Not used

PACR Mode 1 Port A Submode XX Port B Submode X0 PACR

 $\frac{\mathbf{5}}{\mathbf{0}} \ \, \frac{\mathbf{4}}{\mathbf{X}} \ \, \frac{\mathbf{3}}{\mathbf{X}} \ \, \frac{\mathbf{H2 \ Control}}{\mathbf{0} \mathbf{nly}}$

1 X 0 Output pin - always negated

1 X 1 Output pin - always asserted.

PACR

0 H1 Status Control

X Not used.

PACR Mode 1 Port A Submode XX Port B Submode X1 PACR

 $\frac{5}{0}$ $\frac{4}{X}$ $\frac{3}{X}$ Input pin – status only.

1 X 0 Output pin — always negated.

1 X 1 Output pin -- always asserted.

PACR

0 X Not used.

PACR Mode 2

PACR 5 4 3 H2 Control X X 0 Output pip — interlocked output it

X X 0 Output pin — interlocked output handshake protocol

X X 1 Output pin - pulsed output handshake protocol

PACR

0 H1 Status Control

- The H1S status bit is 1 when either the Port B initial or final output latch can accept new data. It is 0 when both latches are full and cannot accept new data.
- 1 The H1S status bit is 1 when both of the Port B output latches are empty. It is 0 when at least one latch is full.

PACR Mode 3

| Ρ | AC | R | | | | |
|-----------|----|---|--------|-----|-----------------|-------|
| 5 | 4 | 3 | | | H2 Co | ntrol |
| \bar{x} | x | 0 | Output | nın | interlocked | outr |

X X 0 Output pin — interlocked output handshake protocol

X X 1 Output pin - pulsed output handshake protocol

PACR

0 H1 Status Control

- 0 The H1S status bit is 1 when either the initial or final output latch of Port A and B can accept new data. It is 0 when both latches are full and cannot accept new data.
- 1 The H1S status bit is 1 when both the initial and final output latches of Ports A and B are empty. It is 0 when either the initial or final latch of Ports A and B is full.

Port B Control Register (PBCR) -

| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------|---|---|--------|-----|---|-----------------------|---|
| Por Subn | | н | 4 Cont | rol | | H3 SVCRQ Enable | |

The Port B Control Register specifies the operation of Port B and the handshake pins H3 and H4 The Port B control register contains five fields bits 7 and 6 specify the Port B submode, bits 5, 4, and 3 control the operation of the H4 handshake pin and H4S status bit, bit 2 determines whether an interrupt will be generated when the H4S status bit goes to 1, bit 1 determines whether a service request (interrupt request or DMA request) will occur, bit 0 controls the operation of the H3S status bit The PACR is always readable and writeable. There is never a consequence to reading the register.

All bits are cleared to 0 when the RESET pin is asserted. When the Port B submode field is relevant in a mode/submode definition, it must not be altered unless the H34 Enable bit in the Port General Control Register is 0

The operation of H3 and H4 and their related status bits is given below, for each of the modes specified by Port General Control Register bits 7 and 6. This description is organized such that for each mode/submode all programmable options of each pin and status bit are given.

Bits 2 and 1 carry the same meaning in each mode/sub-mode, and thus are specified only once

PBCR

2 H4 Interrupt Enable
0 The H4 Interrupt is disabled.
1 The H4 Interrupt is enabled.

PBCR 1

H3 SVCRQ Enable

The H3 interrupt and DMA request are disabled
 The H3 interrupt and DMA request are enabled

PBCR Mode 0 Port B Submode 00

PBCR

5 4 3 H4 Control

0 X X Input pin — status only 1 0 0 Output pin — always negated

1 0 1 Output pin — always asserted.

1 1 0 Output pin — interlocked input handshake protocol

1 1 1 Output pin - pulsed input handshake protocol

PBCR

0 H3 Status Control X Not used

PBCR Mode 0 Port B Submode 01

PBCR

5 4 3 H4 Control

0 X X Input pin — status only. 1 0 0 Output pin — always negated

1 0 1 Output pin — always negated 1 0 1 Output pin — always asserted

1 1 0 Output pin — interlocked output handshake pro-

1 1 1 Output pin - pulsed output handshake protocol.

PBCR

0 H3 Status Control

- The H3S status bit is 1 when either the Port B initial or final output latch can accept new data. It is 0 when both latches are full and cannot accept new data.
- 1 The H3S status bit is 1 when both of the Port B output latches are empty. It is 0 when at least one latch is full

PBCR Mode 0 Port B Submode 1X

PBCR

5 4 3 H4 Control Only.

1 X 0 Output pin - always negated

1 X 1 Output pin — always asserted.

PBCR

0 H3 Status Control
X Not used

PBCR Mode 1 Port B Submode X0

5 4 3 H4 Control

0 X X Input pin — status only

1 0 0 Output pin - always negated.
1 0 1 Output pin - always asserted

1 1 0 Output pin — interlocked input handshake pro-

1 1 1 Output pin — pulsed input handshake protocol

PBCR

H3 Status Control

X Not used

PBCR Mode 1 Port B Submode X1

PRCR

5 4 **H4** Control

- X X Input pin status only 0 0 Output pin - always negated
- 0 1 Output pin always asserted
- 1 0 Output pin interlocked output handshake pro-
- 1 Output pin pulsed output handshake protocol

PBCR

0

H3 Status Control

- $\overline{0}$ The H3S status bit is 1 when either the initial or final output latch of Port A and B can accept new data. It is 0 when both latches are full and cannot accept new
- The H3S status bit is 1 when both the initial and final output latches of Ports A and B are empty. It is 0 when neither the initial or final latch of Ports A and B is full

PBCR Mode 2

PBCR

4 **H4 Control**

 \bar{x} 0 Output pin - interlocked input handshake pro-

X X 1 Output pin - pulsed input handshake protocol

PBCR

 \bar{x}

H3 Status Control

Not used

PBCR Mode 3

PBCR

5 4 3

H4 Control

X X 0 Output pin - interlocked input handshake pro-

X X 1 Output pin - pulsed input handshake protocol

PBCR

H3 Status Control

Not used

Port A Data Register (PADR) - The Port A Data Register is an address for moving data to and from the Port A pins The Port A Data Direction Register determines whether each pin is an input (0) or an output (1), and is used in configuring the actual data paths. This is mode dependent and is described with the modes above

This register is readable and writeable at all times Depending on the chosen mode/submode, reading or writing may affect the double-buffered handshake mechanism. The Port A Data Register is not affected by the assertion of the RESET pin

Port B Data Register (PBDR) - The Port B Data Register is an address for moving data to and from the Port B pins The Port B Data Direction Register determines whether each pin is an input (0)or an output (1), and is used in configuring the actual data paths. This is mode dependent and is described with the modes, above

This register is readable and writeable at all times. Depending on the chosen mode/submode, reading or writing may affect the double-buffered handshake mechanism. The Port B Data Register is not affected by the assertion of the RESET

Port A Alternate Register (PAAR) - The Port A Alternate Register is an alternate address for reading the Port A pins. It is a read-only address and no other PI/T condition is affected. In all modes and the instantaneous pin level is read and no input latching is performed except at the data bus interface (see Bus Interface Connection) Writes to this address are answered with DTACK, but the data is ignored

Port B Alternate Register (PBAR) - The Port B Alternate Register is an alternate address for reading the Port B pins. It is a read-only address and no other PI/T condition is affected In all modes the instantaneous pin level is read and no input latching is performed except at the data bus interface (see Bus Interface Connection) Writes to this address are answered with DTACK, but the data is ignored

Port C Data Register (PCDR) - The Port C Data Register is an address for moving data to and from each of the eight Port C/alternate-function pins The exact hardware accessed is determined by the type of bus cycle (read or write) and individual conditions affecting each pin. These conditions are (1) whether the pin is used for the Port C or alternate function, and (2) whether the Port C Data Direction Register indicates the input or output direction. The Port C Data Register is single buffered for output pins and not buffered for input pins. These conditions are summarized in Table 11

The Port C Data Register is not affected by the assertion of the RESET pin

The operation of the PCDR is independent of the chosen PI/T mode

TABLE 11 - PCDR HARDWARE ACCESSES

| Read Port C Data Register | | | | | | | | |
|---|--|------------------------------------|------------------------------------|--|--|--|--|--|
| Port C function PCDDR = 0 | Port C function PCDDR = 1 | Alternate function PCDDR = 0 | Alternate function PCDDR = 1 | | | | | |
| pin | Port C output register Write Port C I | out pin ster | | | | | | |
| | | | | | | | | |
| Port C Function PCDDR = 0 | Port C Function PCDDR = 1 | Alternate function PCDDR = 0 | Alternate function PCDDR = 1 | | | | | |
| Port C output register, buffer disabled | Port C output register, buffer enabled | Port C output register | Port C output register | | | | | |

Note that two additional useful benefits result from this structure. First, it is possible to directly read the state of a dual-function pin while used for the non-Port C function. Second, it is possible to generate program controlled transitions on alternate-function pins by switching back to the Port C function, and writing to the PCDR.

This register is readable and writeable at all times

Port Status Register (PSR) -

| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------|-------------|-------------|---|-----|-----|-----|-----|
| H4 Level | H3 Level | H2 Level | | H4S | H3S | H2S | H1S |

The Port Status Register contains information about handshake pin activity. Bits 7-4 show the instantaneous level of the respective handshake pin, and is independent of the handshake pin sense bits in the Port General Control Register. Bit 3-0 are the respective, status bits referred to throughout this data sheet. Their interpretation depends on the programmed mode/submode of the PI/T. For Bits 3-0 a 1 is the active or asserted state.

Timer Control Register (TCR) -

| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---|------------------|---|-------------|---|---|--------------|-----------------|
| | UT/TIA Contro | | Z D Ctrl | * | | ock ntrol | Timer Enable |

The Timer Control Register (TCR) determines all operations of the timer Bits 7-5 configure the PC3/TOUT and PC7/TIACK pins for Port C, square wave, vectored interrupt, or autovectored interrupt operation, bit 4 specifies whether the counter receives data from the Counter Preload Register or continues counting when zero detect is reached, bit 3 is unused and is read as 0, bits 2 and 1 configure the path from the CLK and TIN pins to the counter controller, bit 0 enables the timer. This register is readable and writeable at all times.

All bits are cleared to 0 when the RESET pin is asserted

TCR

7 6 5 TOUT/TIACK Control

- 0 X X The dual-function pins PC3/TOUT and PC7/TIACK carry the Port C function
- 0 1 X The dual-function pin PC3/TOUT carries the TOUT function. In the run state it is used as a square wave output and is toggled on zero detect. The TOUT pin is high while in the halt state. The dual-function pin PC7/TIACK carries the PC7 function.
- 1 0 0 The dual-function pin PC3/TOUT carries the TOUT function. In the run or halt state it is used as a timer interrupt request output. The timer interrupt is disabled, thus, the pin is always three-stated. The dual-function pin PC7/TIACK carries the TIACK function, however, since interrupt request is negated, the PI/T produces no response, i.e., no data or DTACK, to an asserted TIACK. Refer to Timer Interrupt Cycle section for details. This combination and the 101 state below support vectored timer interrupts.

- 1 0 1 The dual-function pin PC3/TOUT carries the TOUT function and is used as a timer interrupt request output The timer interrupt is enabled, thus, the pin is low when the timer ZDS status bit is 1 The dual function pin PC7/TIACK carries the TIACK function and is used as a timer interrupt acknowledge input Refer to the Timer Interrupt Acknowledge Cycle section for details This combination and the 100 state above support vectored timer interrupts
- 1 1 0 The dual-function pin PC3/TOUT carries the TOUT function. In the run or halt state it is used as a timer interrupt request output. The timer interrupt is disabled, thus, the pin is always three-stated. The dual-function pin PC7/TIACK carries the PC7 function.
- 1 1 The dual-function pin PC3/TOUT carries the TOUT function and is used as a timer interrupt request output. The timer interrupt is enabled, thus, the pin is low when the timer ZDS status bit is 1. The dual-function pin PC7/TIACK carries the PC7 function and autovectored interrupts are supported.

TCR

Zero Detect Control

- 0 The counter is loaded from the Counter Preload Register on the first clock to the 24-bit counter after zero detect, and resumes counting
- 1 The counter rolls over on zero detect, then continues counting

Bit 3 is unused and is always read as 0

TCR

2 1 Clock Control

- 0 The PC2/TIN input pin carries the Port C function and the CLK pin and prescaler are used. The prescaler is decremented on the falling transition of the CLK pin, the 24-bit counter is decremented or loaded from the Counter Preload Registers when the prescaler rolls over from \$00 to \$1F. The Timer Enable bit determines whether the timer is in the run or halt state.
- 0 1 The PC2/TIN pin serves as a timer input and the CLK pin and prescaler are used. The prescaler is decremented on the falling transition of the CLK pin, the 24-bit counter is decremented or loaded from the Counter Preload Registers when the prescaler rolls over from \$00 to \$1F. The timer is in the run state when the Timer Enable bit is 1 and the TIN pin is high, otherwise the timer is in the halt state.
- 1 0 The PC2/TIN pin serves as a timer input and the prescaler is used. The prescaler is decremented following the rising transition of the TIN pin after syncing with the internal clock. The 24-bit counter is decremented or loaded from the counter preload registers when the prescaler rolls over from \$00 to \$1F. The Timer Enable bit determines whether the timer is in the run or halt state.
- 1 1 The PC2/TIN pin serves as a timer input and the prescaler is unused. The 24-bit counter is decremented or loaded from the Counter Preload Registers following the rising edge of the TIN pin after syncing with the internal clock. The Timer Enable bit determines whether the timer is in the run or halt state.

TCR

0 Disabled 1 Enabled

Timer Enable

Timer Interrupt Vector Register (TIVR) — The timer interrupt vector register contains the 8-bit vector supplied when the timer interrupt acknowledge pin TIACK is asserted. The register is readable and writeable at all times, and the same value is always obtained from a normal read cycle and a timer interrupt acknowledge bus cycle (TIACK). When the RESET pin is asserted the value of \$0F is automatically loaded into the register. Refer to Timer Interrupt Acknowledge Cycle section for more details.

Counter Preload Register H, M, L (CPRH-L)

| | 0 | 1 | 2 | 3 | 4 | 5 | 6 | 7 |
|------|-----|-----|-----|-----|-----|-----|-----|-----|
| CPRH | Bit | Bit | Bit | Bit | Bit | Bit | Bit | Bit |
| | 16 | 17 | 18 | 19 | 20 | 21 | 22 | 23 |
| CPRM | Bit | Bit | Bit | Bit | Bit | Bit | Bit | Bit |
| | 8 | 9 | 10 | 11 | 12 | 13 | 14 | 15 |
| CPRL | Bit | Bit | Bit | Bit | Bır | Bit | Bit | Bit |
| | 0 | 1 | 2 | 3 | 4 | 5 | 6 | 7 |

The Counter Preload Registers are a group of three 8-bit registers used for storing data to be transferred to the counter Each of the registers is individually addressable, or the group may be accessed with the MOVEP L or the MOVEP W instructions. The address one less than the address of CPRH is the null register, and is reserved so that zeros are read in the upper 8 bits of the destination data register when a MOVEP L is used. Data written to this address is ignored.

The registers are readable and writeable at all times. A read cycle proceeds independently of any transfer to the counter, which may be occurring simultaneously.

To insure proper operation of the PI/T Timer, a value of \$000000 may not be stored in the Counter Preload Registers for use with the counter

The RESET pin does not affect the contents of these registers.

Count Register H, M, L (CNTRH-L) -

| | 0 | 1 | 2 | 3 | 4 | 5 | 6 | 7 |
|-------|-----|-----|-----|-----|-----|-----|-----|-----|
| CNTRH | Bit | Bit | Bit | Bit | Bıt | Bit | Bıt | Bit |
| | 16 | 17 | 18 | 19 | 20 | 21 | 22 | 23 |
| CNTRM | Bit | Bit | Bit | Bit | Bıt | Bit | Bit | Bit |
| | 8 | 9 | 10 | 11 | 12 | 13 | 14 | 15 |
| CNTRL | Bit | Bit | Bit | Bit | Bıt | Bit | Bit | Bit |
| | 0 | 1 | 2 | 3 | 4 | 5 | 6 | 7 |

The count registers are a group of three 8-bit addresses at which the counter can be read. The contents of the counter are not latched during a read bus cycle; thus, the data read at these addresses is not guaranteed if the timer is in the run.

state (Bits 2, 1, and 0 of the Timer Control Register specify the state) Write operations to these addresses result in a normal bus cycle but the data is ignored

Each of the registers is individually addressable, or the group may be accessed with the MOVEP L or the MOVEP W instructions. The address one less than the address of CNTRH is the null register, and is reserved so that zeros are read in the upper 8 bits of the destination data register when a MOVEP L is used. Data written to this address is ignored.

Timer Status Register (TSR) -

| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---|---|---|---|---|---|---|-----|
| * | * | * | * | * | * | * | ZDS |

The Timer Status Register contains one bit from which the zero detect status can be determined. The ZDS status bit (bit 0) is an edge-sensitive flip-flop that is set to 1 when the 24-bit counter decrements from \$000001 to \$000000. The ZDS status bit is cleared to 0 following the direct clear operation (similar to that of the ports), or when the timer is halted Note also that when the RESET pin is asserted the timer is disabled, and thus enters the halt state.

This register is always readable without consequence. A write access performs a direct clear operation if bit 0 in the written data is 1. Following that, the ZDS bit is 0.

This register is constructed with a reset dominant S-R flipflop so that all clearing conditions prevail over the possible zero detect condition

Bits 7-1 are unused and are read as 0

TIMER APPLICATIONS SUMMARY

This section outlines programming of the Timer Control Register for several typical examples

Periodic Interrupt Generator

| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|------------|---------|---|-----|---|------------------|------|---------|
| TOUT/TIACK | | | Z D | , | Clock Control | | Timer |
| | Control | | | * | | | Enable |
| 1 | X | 1 | 0 | 0 | 00 о | r 1X | changed |

In this configuration the timer generates a periodic interrupt. The TOUT pin is connected to the system's interrupt request circuitry and the $\overline{\text{TIACK}}$ pin may be used as an interrupt acknowledge input to the timer. The TIN pin may be used as a clock input.

The processor loads the Counter Preload Registers and Timer Control Register, and then enables the timer When the 24-bit counter passes from \$000001 to \$000000 the ZDS status bit is set and the TOUT (interrupt request) pin is asserted. At the next clock to the 24-bit counter it is again loaded with the contents of the CPR's, and thereafter decrements. In normal operation, the processor must direct clear the status bit to negate the interrupt request.

Square Wave Generator

| | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---|---------|--------|----|------|---|------|-------|---------|
| | TOL | JT/TIA | CK | Z D | | Clo | Timer | |
| ı | Control | | | Ctrl | * | Cor | itrol | Enable |
| | 0 | 1 | X | 0 | 0 | 00 ი | r 1X | changed |

In this configuration the timer produces a square wave at the TOUT pin The TOUT pin is connected to the user's circuitry and the $\overline{\mathsf{TIACK}}$ pin is not used. The TIN pin may be used as a clock input

The processor loads the Counter Preload Registers and Timer Control Register, and then enables the timer. When the 24-bit counter passes from \$000001 to \$000000 the ZDS status bit is set and the TOUT (square wave output) pin is toggled. At the next clock to the 24-bit counter it is again loaded with the contents of the CPRs, and thereafter decrements. In this application there is no need for the processor to direct clear the ZDS status bit, however, it is possible for the processor to Sync itself with the square wave by clearing the ZDS status bit, then polling it. The processor may also read the TOUT level at the Port C address.

Note that the <u>PC3/TOUT</u> pin functions as PC3 following the negation of <u>RESET</u> If used in the square wave configuration a pullup resistor may be required to keep a known level prior to programming Prior to enabling the timer, TOUT is high

Interrupt After Timeout

| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|----|------------------|---|-------------|---|------|--------------|-------------|
| ТО | UT/TIA Contro | | Z D Ctrl | * | | ock ntrol | Timer En |
| 1 | X | 1 | 1 | 0 | 00 0 | or 1X | changed |

In this configuration the timer generates an interrupt after a programmed time period has expired. The TOUT pin is connected to the system's interrupt request circuitry and the TIACK pin may be an interrupt acknowledge input to the timer. The TIN pin may be used as a clock input.

This configuration is similar to the periodic interrupt generator except that the Zero Detect Control bit is set. This forces the counter roll over after Zero Detect is reached, rather than reloading from the CPRs. When the processor takes the interrupt it can halt the timer and read the counter. This allows the processor to measure the delay time from Zero Detect (interrupt request) to entering the service routine. Accurate knowledge of the interrupt latency may be useful in some applications.

Elapsed Time Measurement

Elapsed time measurement takes several forms, two are described below

System Clock

| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|----|-----------------------|---|-----------|---|---|--------------|-----------------|
| TC | TOUT/TIACK Control | | | * | | ock ntrol | Timer Enable |
| 0 | 0 | X | Ctrl 1 | 0 | 0 | 0 | changed |

This configuration allows time interval measurement by software. No timer pins are used

The processor loads the Counter Preload Registers (generally with all 1s) and Timer Control Register, and then enables the timer. The counter decrements until the ending event takes place. When it is desired to read the time interval, the processor must halt the timer, then read the counter

For applications in which the interval could have exceeded that programmable in this timer, interrupts can be counted to provide the equivalent of additional timer bits. At the end, the timer can be halted and read

External Clock

| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---|------------------|---|-------------|---|---|--------------|-----------------|
| | UT/TIA Contro | | Z D Ctrl | * | | ock ntrol | Timer Enable |
| 0 | 0 | X | 1 | 0 | 1 | X | changed |

This configuration allows measurement (counting) of the number of input pulses occurring in an interval in which the counter is enabled. The TIN input pin provides the input pulses. Generally the TOUT and $\overline{\text{TIACK}}$ pins are not used

This configuration is identical to the Elapsed Time Measurement/System Clock configuration except that the TIN pin is used to provide the input frequency. It can be connected to a simple oscillator, and the same methods could be used. Alternately, it could be gated off and on externally and the number of cycles occurring while in the run state can be counted. However, minimum pulse width high and low specifications must be met.

Device Watchdog

| | | | | | | - | | |
|---|----|--------|------------|------|---|-----|-------|---------|
| | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| 1 | TO | UT/TIA | NCK | Z D | | CI | ock | Timer |
| | | Contro | l | Ctrl | * | Cor | ntrol | Enable |
| | 1 | X | 1 | 1 | 0 | 0 | 1 | changed |

This configuration provides the watchdog function needed in many systems. The TIN pin is the timer input whose period at the high (1) level is to be checked. Once allowed by the processor, the TIN input pin controls the run/halt mode. The TOUT pin is connected to external circuitry requiring notification when the TIN pin has been asserted longer than the programmed time. The TIACK pin (interrupt acknowledge) is only needed if the TOUT pin is connected to interrupt circuitry.

The processor loads the Counter Preload Register and Timer Control Register, and then enables the timer When the TIN input is asserted (1, high) the timer transfers the contents of the Counter Preload Register to the counter and begins counting. If the TIN input is negated before Zero Detect is reached, the TOUT output and the ZDS status bit remain negated. If Zero Detect is reached while the TIN input is still asserted the ZDS status bit is set and the TOUT output is asserted. (The counter rolls over and keeps on counting.)

In either case, when the TIN input is negated the ZDS status bit is 0, the TOUT output is negated, the counting stops, and the prescaler is forced to all 1s

BUS INTERFACE CONNECTION

The PI/T has an asynchronous bus interface, primarily designed for use with the MC68000 microprocessor. With care, however, it can be connected to synchronous microprocessor buses. This section completely describes the PI/T's bus interface, and is intended for the asynchronous bus designer unless otherwise mentioned.

In an asynchronous system the PI/T CLK may operate at a significantly different frequency, either higher or lower, than the bus master and other system components, as long as all bus specifications are met The MC68230 CLK pin has the same specifications as the MC68000 CLK, and must not be gated off at any time

The following signals generate normal read and write cycles to the PI/T \overline{CS} (Chip Select), R/ \overline{W} (Read/Write), RS1-RS5 (five Register Select bits), D0-D7 (the 8-bit bidirectional data bus), and \overline{DTACK} (Data Transfer Acknowledge). To generate interrupt acknowledge cycles PC6/PIACK or PC7/TIACK is used instead of \overline{CS} , and the Register Select pins are ignored. No combination of the following pins may be asserted simultaneously \overline{CS} , PIACK, or TIACK

READ CYCLES VIA CHIP SELECT

This catagory includes all register reads, except port or timer interrupt acknowledge cycles. When $\overline{\mathbb{CS}}$ is asserted, the Register Select and R/ $\overline{\mathbb{W}}$ inputs are latched internallly. They must meet small setup and hold time requirements with respect to the asserted edge of $\overline{\mathbb{CS}}$ (See the AC ELECTRICAL CHARACTERISTICS table.) The PI/T is not protected against aborted (shortened) bus cycles generated by an Address Error or Bus Error exception in which it is addressed.

Certain operations triggered by normal read (or write) bus cycles are not complete within the time allotted to the bus cycle One example is transfers to/from the double-buffered latches that occur as a result of the bus cycle. If the bus master's CLK is significantly faster than the PI/T's the possibility exists that, following the bus cycle, CS can be negated then re-asserted before completion of these internal operations. In this situation the PI/T does not recognize the re-assertion of CS until these operations are complete. Only at that time does it begin the internal sequencing necessary to react to the asserted \overline{CS} Since \overline{CS} also controls the DTACK response, this "bus cycle recovery time" can be related to the CLK edge on which DTACK is asserted for that cycle The PI/T will recognize the subsequent assertion of CS three (3) CLK periods after the CLK edge on which DTACK was previously asserted

The Register Select and R/\overline{W} inputs pass through an internal latch that is transparent when the PI/T can recognize a new \overline{CS} pulse (see above paragraph). Since the internal data bus of the PI/T is continuously enabled for read transfers, the read access time (to the data bus buffers) begins when the Register Selects are stabilized internally Also, when the PI/T is ready to begin a new bus cycle, the assertion of \overline{CS} enables the data bus buffers within a short propagation delay. This does not contribute to the overall read access time unless \overline{CS} is asserted significantly after the Register Select and R/\overline{W} inputs are stabilized (as may occur with synchronous bus microprocessors)

In addition to Chip Select's previously mentioned duties, it controls the assertion of $\overline{\text{DTACK}}$ and latching of read data at the data bus interface. Except for controlling input latches

and enabling the data bus buffers, all of these functions occur only after \overline{CS} has been recognized internally and synchronized with the internal clock. Chip Select is recognized on the falling edge of the CLK if the setup time is met, \overline{DTACK} is asserted (low) on the next falling edge of the CLK. Read data is latched at the PI/T's data bus interface at the same time \overline{DTACK} is asserted. It is stable as long as Chip Select remains asserted independent of other external conditions.

From the above discussion it is clear that if the $\overline{\text{CS}}$ setup time prior to the falling edge of the CLK is met, the PI/T can consistently respond to a new read or write bus cycle every four (4) CLK cycles This fact is especially useful in designing the PI/T's clock in synchronous bus systems not using $\overline{\text{DTACK}}$ (An extra CLK period is required in interrupt acknowledge cycles, see Read Cycles via Interrupt Acknowledge)

In asynchronous bus systems in which the PI/T's CLK differs from that of the bus master, generally there is no way to guarantee that the $\overline{\text{CS}}$ setup time with respect to the PI/T CLK is met Thus, the only way to determine that the PI/T recognized the assertion of $\overline{\text{CS}}$ is to wait for the assertion of $\overline{\text{DTACK}}$ In this situation, all latched bus inputs to the PI/T must be held stable until $\overline{\text{DTACK}}$ is asserted. These include Register Select, R/\overline{W} , and write data inputs (see below)

System specifications impose a maximum delay from the trailing (negated) edge of Chip Select to the negated edge of DTACK. As system speeds increase this becomes more difficult to meet with a simple pullup resistor tied to the $\overline{\text{DTACK}}$ line. Therefore, the PI/T provides an internal active pullup device to reduce the rise time, and a level-sensitive circuit that later turns this device off $\overline{\text{DTACK}}$ is negated asynchronously as fast as possible following the rising edge of Chip Select, then three-stated to avoid interference with the next bus cycle.

The system designer must take care that DTACK is negated and three-stated quickly enough after each bus cycle to avoid interference with the next one. With the MC68000 this necessitates a relatively fast external path from the data strobe to CS going negated.

WRITE CYCLES

In many ways write cycles are similar to normal read cycles (see above). On write cycles, data at the D0-D7 pins must meet the same setup specifications as the Register Select and R/ \overline{W} lines. Like these signals, write data is latched on the asserted edge of \overline{CS} , and must meet small setup and hold time requirements with respect to that edge. The same bus cycle recovery conditions exist as for normal read cycles. No other differences exist

READ CYCLES VIA INTERRUPT ACKNOWLEDGE

Special internal operations take place on PI/T interrupt acknowledge cycles. The Port Interrupt Vector Register or the Timer Interrupt Vector Register are implicitly addressed by the assertion of PC6/PIACK or PC7/TIACK, respectively. The signals are first synchronized with the falling edge of the CLK. One clock period after they are recognized the data bus buffers are enabled and the vector is driven onto the bus $\overline{\text{DTACK}}$ is asserted after another clock period to allow the vector some setup time prior to $\overline{\text{DTACK}}$. $\overline{\text{DTACK}}$ is negated, then three-stated as with normal read or write cycle, when $\overline{\text{PIACK}}$ is negated



MC68450

Product Preview

DIRECT MEMORY ACCESS CONTROLLER

Microprocessor implemented systems are becoming increasingly complex, particularly with the advent of high-performance 16-bit MPU devices with large memory addressing capability. In order to maintain high throughput, large blocks of data must be moved within these systems in a quick, efficient manner with minimum intervention by the MPU itself.

The MC68450 Direct Memory Access Controller (DMAC) is designed specifically to complement the performance and architectural capabilities of the MC68000 MPU by providing the following features:

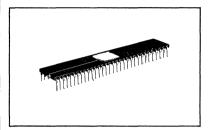
- M68000 Bus Compatible
- 4 Independent DMA Channels
- Memory-to-Memory, Memory-to-Device, Device-to-Memory Transfers
- Array-Chained and Linked-Array-Chained Operations
- On-Chip Registers that allow Complete Software Control by the System MPU
- Interface Lines that Provide for Requesting, Acknowledging, and Incidental Control of the Peripheral Devices
- Transfers to/from M68000 or M6800 Peripherals
- Variable System Bus Bandwidth Utilization
- Programmable Channel Prioritization
- 2 Vectored Interrupts for each Channel
- Auto-Request and External-Request Transfer Modes
- Up to 4 Megabytes/Second Transfer Rates
- +5 Volt Operation

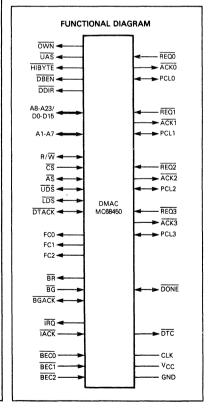
The DMAC functions by transferring a series of operands (data) between memory and device; operand sizes can be byte, word, or long word. A block is a sequence of operations, the number of operands in a block is determined by a transfer count. A single-channel operation may involve the transfer of several blocks of data between memory and device.

HMOS

(HIGH DENSITY N-CHANNEL, SILICON-GATE DEPLETION LOAD)

DMA CONTROLLER





GENERAL FEATURES

DATA TRANSFER MODES

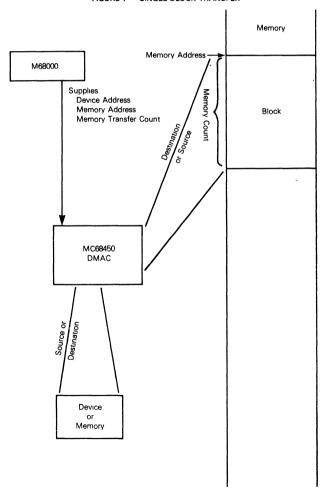
There are three modes for transferring data: 1) single block transfers, 2) continued operation, and 3) chained operations. The first two modes utilize on-chip registers while the last mode uses an on-chip address register to point to operational parameters stored in external RAM.

When transferring single blocks of data, the memory address and device address registers are initialized by their user to specify the source and destination of the transfer. Also initialized, is the memory transfer count register to count the number of operands transferred in a block. Repeated block

transfers are possible with the memory address and transfer count registers being automatically reinitialized upon completion of a block transfer. See Figure 1

The two chaining modes are array chaining and linked array chaining. The array chaining mode operates from a contiguous array in memory consisting of memory addresses and transfer counts. The base address register and base transfer count register are initialized to point to the beginning address of the array and the number of array entries, respectively. As each block transfer is completed, the next entry is fetched from the array. The base transfer count is

FIGURE 1 - SINGLE BLOCK TRANSFER



decremented, and the base address is incremented to point to the next array entry. When the base transfer count reaches zero, the entry just fetched is the last block transfer defined in the array. See Figure 2.

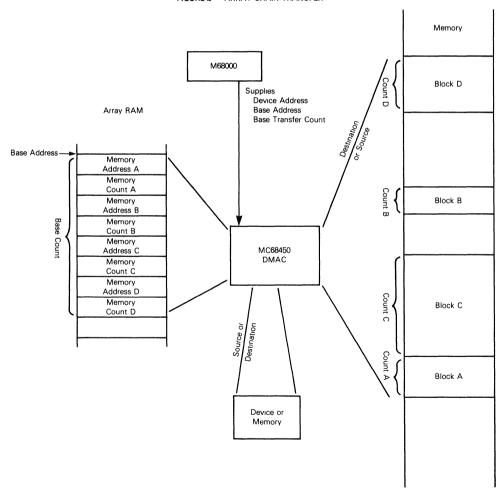
The linked array chaining mode is similar to the array chaining mode, except that each entry in the memory array also contains a link address which points to the next entry in the array. This allows a non-contiguous memory array The last entry contains a link address set to zero. No base transfer count register is needed in this mode. The base address register is initialized to the address of the first entry in the array. The link address is used to update the base address register at the beginning of each block transfer. This

chaining mode allows array entries to be easily moved or inserted without having to reorganize the array into sequential order. Also, the number of entries in the array need not be specified to the DMAC See Figure 3.

INTERRUPT OPERATION

The DMAC will interrupt the MPU for a number of event occurrences such as the completion of a DMA operation, or at the request of a peripheral device using a PCL line. The user must write interrupt vectors into an on-chip vector register, for use on the M68000 vectored interrupt structure. Two vector registers are available for each channel.

FIGURE 2 - ARRAY CHAIN TRANSFER



CHANNEL PRIORITY

Each channel may be given a priority level of 0, 1, 2, or 3. If several channel requests occur at the same priority level, a round-robin priority mode is entered automatically.

REQUEST MODES - AUTO-REQUEST

Requests may be externally generated by a device or internally generated by the DMAC's auto-request mechanism. Auto-requests may be generated at the maximum rate, where the channel always has a request pending, or at a limited rate determined by selecting a proportion of the bus bandwidth.

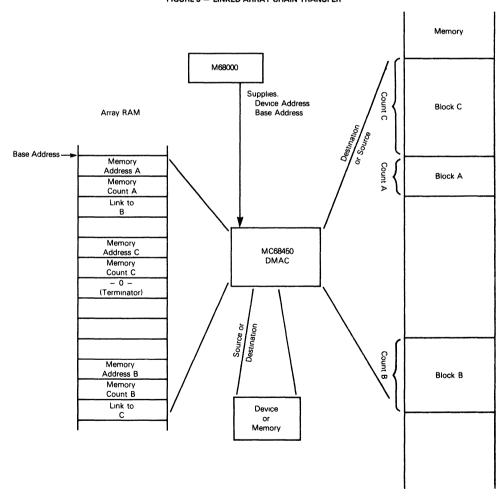
DEVICE PROTOCOLS

The DMAC can communicate using any of the following protocols:

- 1) MC68000 compatible device
- 2) MC6800 compatible device
- 3) Device with acknowledge
- 4) Device with acknowledge and ready

In the first two protocols, data is transferred from the source to an internal DMAC holding register, and then on the next bus cycle moved from the holding register to the

FIGURE 3 - LINKED ARRAY CHAIN TRANSFER



destination. Protocols 3 and 4 require only one bus cycle for data transfer, since only one device needs to be addressed. With these protocols, communication is performed using a two-signal and three-signal handshake, respectively

INTERNAL REGISTERS

The DMAC contains seventeen on-chip registers for each of the four channels plus one general control register. All of these registers are under software control of the system MPU. These registers are shown in Figure 4.

These registers contain status information on channel activity, PCL inputs, and various errors which can occur during DMA transfers. The type of transfer, operand size, device port size and type, use of the PCL, chaining mode, stepping direction, and transfer start/stop are all controlled through these registers. For data transfers, registers allow selection of channel priority, function codes, memory and device addresses, transfer count, and chaining table address and length. The general control register selects the bus utilization factor to be used in DMA operations.

Address/Data (A8-A23/D0-D15) — Address (ouput) and data (input/output) are time-multiplexed.

Lower Address Bits (A1-A7) — These lines serve two purposes. They address internal control/status registers as well as serving as the low order address bits of the location addressed during DMA operations.

M68000 Asynchronous Bus Interface Controls (AS, LDS, UDS, R/W, DTACK) — Bidirectional M68000 asynchronous bus control lines for both register operations in the chip and for DMAC operation.

Chip Select (CS) — In conjunction with A1-A7 address lines, CS selects registers in the DMAC.

M68000 Asynchronous Bus Arbitration Controls (BR, BG, BGACK) — Allow the DMAC to gain mastership of the bus prior to a DMA operation.

Bus Exception Controls (BEC0-BEC2) — These lines provide an encoded signal which indicates different bus conditions/commands to the DMAC such as reset, bus error, halt, retry, and others.

Function Codes (FC0-FC2) — During a DMA bus cycle, these three output lines will provide M68000 function codes. The codes are user programmable on each channel and can be used in conjunction with a memory management system.

Peripheral Device Control Lines (REQ, ACK, PCL) — Each of the four channels has a set of these signals. Request (REQ) is an input from the peripheral device requesting a DMA operation. Acknowledge (ACK) is an output when the DMAC has gained control of the system bus. The peripheral control lines (PCL) are bidirectional and serve a variety of

FIGURE 4 - DMAC ACCESSIBLE REGISTERS General One Per DMAC Control Register Status Register Channel Error Register Device Control Register Operation Control Register Control Register Channel Control Register Normal One Set Per Interrupt Vector Channel Error Interrupt Vector Channel Priority Register Memory Function Codes Device Function Codes Base Function Codes 15 Memory Transfer Counter Base Transfer Counter 31 Memory Address Register Device Address Register Base Address Register

4-816

functions which are selected by the user. The desired function is selected by the programmed state of an internal control register. These functions include an E (ϕ 2) clock for M6800 peripherals, a sense (status) input, an interrupt request from the peripheral device, a single pulse to indicate that the DMAC channel is armed, an abort input, or a ready input from a slow interfaced device.

Done — This bidirectional line is used to indicate the completion of a DMA operation or to terminate a DMA operation when asserted externally.

Device Transfer Complete (DTC) — The DTC line is an output used to signal the device that the data transfer is complete. On a write-to-memory operation, it indicates that the data has been successfully stored. On a read-frommemory operation, it indicates that the data is present at the device and should be latched.

Clock (CLK) - The system MPU clock

Interrupt Request and Interrupt Acknowledge (IRQ and

IACK) - M68000 interrupt controls

Multiplex Control Lines (UAS, OWN, DDIR, DBEN) — These lines are used to control the multiplexing on the shared address/data pins, and bidirectional buffers in a buffered system. Use of these lines is shown in Figure 5.

Upper Addres Strobe (UAS) — is used to latch the upper address bits (A8-A23) on the multiplexed address/data bus. The data direction (DDIR) line is used to indicate the direction of data to/from the DMAC, for external bidirectional buffers. The data bus enable (DBEN) line controls the output of bidirectional buffers on the multiplexed address/data bus. The OWN signal is asserted when the DMAC has gained bus mastership, for use in a buffered system to control direction on the bidirectional lines

High Byte (HIBYTE) — This signal indicates that data is present on the upper eight data bits when the operands are only one byte wide

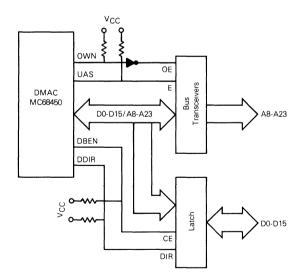


FIGURE 5 - DMA CONTROLLER EXTERNAL COMPONENTS



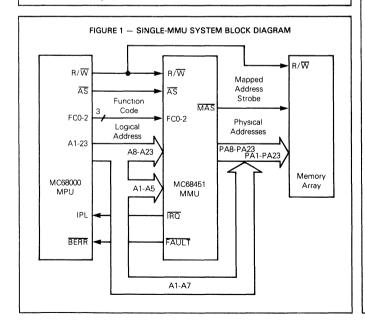
MC68451

Product Preview

MEMORY MANAGEMENT UNIT (MMU)

The MC68451 Memory Management Unit (MMU) provides address translation and protection for the 16 megabyte addressing range of the MC68000 MPU Each bus master (or processor) in the M68000 Family provides a function code and an address during each bus cycle. The function code specifies an address space and the address specifies a location within that address space. The function codes distinguish between User and Supervisor spaces and, within these, between Data and Program spaces. This separation of address spaces provides the basis for memory management and protection by the operating system. Provision is also made for other bus masters, such as the MC68450 DMAC, to have separate address spaces for efficient DMA. A multi-tasking operating system is simplified and reliability is enhanced through the use of the MMU.

- MC68000 Bus Compatible
- Provides Efficient Memory Allocation
- Separates Address Spaces of System and User Resources
- Provides Write Protection
- Supports Paging and Segmentation
- 32 Segments of Variable Size with Each MMU
- Multiple MMU Capability to Expand to Any Number of Segments
- Allows Inter-Task Communication through Shared Segments
- Quick Context Switching to Cut Operating System Overhead
- Simplifies Programming Model of Address Space
- Increases System Reliability
- DMA Compatible

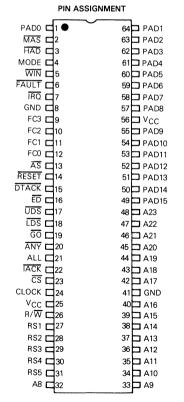


HMOS

(HIGH-DENSITY N-CHANNEL, SILICON-GATE)

MEMORY MANAGEMENT UNIT





GENERAL DESCRIPTION

The MC68451 Memory Management Unit (MMU) is the basic element of a Memory Management Mechanism (MMM) in an MC68000-based system. The operating system is responsible for insuring the proper execution of user tasks in the system environment and memory management is basic to this responsibility. The MMM provides the operating system with the capability to allocate, control, and protect the system memory. A block diagram of a single-MMU system is shown in Figure 1.

An MMM, implemented with one or more MC68451 MMUs, can provide address translation, separation, and write protection for the system memory. The MMM can be programmed to cause an interrupt when a chosen section of memory is accessed and can directly translate a logical address into a physical address making it available to the MPU for use by the operating system. Using these features, the MMM can provide separation and security for user programs and allow the operating system to manage the memory in an efficient fashion for multi-tasking.

MEMORY SEGMENTS

The MMM partitions the logical address space into contiguous pieces called segments. Each segment is a section of the logical address space of a task which is mapped via the MMM into the physical address space. Each task may have any number of segments. Segments may be defined as user or supervisor, data-only or program-only, or program and data. They may be accessed by only one task or shared between two or more tasks. In addition, any segment can be write protected to insure system integrity. A FAULT (MC68000 Bus Error) is generated by the MMM if an undefined segment is accessed.

FUNCTION CODES AND ADDRESS SPACES

Each bus master in the M68000 family (including the MC68450 DMACI) provides a function code during each bus cycle to indicate the address space to be used for that cycle. The address bus then specifies a location within this address space for the operation taking place during that bus cycle.

The function codes appear on the FC0-FC2 lines of the MC68000 and divide the memory references into two logical address spaces — the Supervisor and the User spaces Each of these is further divided into Program and Data spaces A separate address space is also provided for interrupt acknowledge bus cycles giving a total of five defined function codes

In addition to the 3-bit function code provided by the MC68000, the MC68451 MMU also allows a fourth bit (FC3) which provides for the possibility of another bus master in the system In this case, FC3 would be tied to Bus Grant Acknowledge (BGACK) of the MC68000 to enable a second set of eight function codes This raises the total number of

possible function codes to sixteen. If there is only one bus master (the MPU), the FC3 pin on the MMU should be tied low and only eight address spaces can then be used.

ADDRESS SPACE NUMBERS

To separate the address spaces of different tasks, each address space is given an identifying number. This should not be confused with the address space indicated by the function code. Each function code defines a unique address space and within each of these there can exist a number of different tasks. Each of these tasks need an Address Space. Number (ASN) to distinguish it from the other tasks with which it may share an address space.

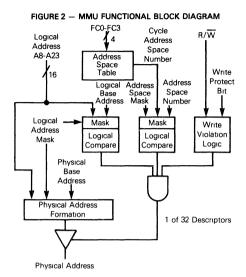
The Address Space Numbers are kept in the MMU in a set of registers called the Address Space Table (AST). The AST contains an 8-bit entry for each possible function code (16). Each entry can be assigned an ASN and, during a bus cycle, the function code is used to index into this table to select the Cycle. Address. Space. Number. This number is then associatively compared with the Address Space. Numbers in each Descriptor to attempt to find a match.

DESCRIPTORS

Address translation is done using Descriptors A Descriptor is a set of six registers (nine bytes) which describe a memory segment and how that segment is to be mapped to the physical addresses Each Descriptor contains base addresses for the Logical and Physical spaces of each segment These base addresses are then masked with the Logical Address Masks The size of the segment is then defined by "don't cares" in the low-order bits of the masks. This method allows segment sizes from a minimum of 256 bytes to a maximum of 16 megabytes in binary increments (i.e., powers of two) This also forces both logical and physical addresses of segment boundaries to lie on a segment size boundary That is, a segment can only start on an address which is a multiple of 2k The segments can be defined in such a way to allow them to be logically or physically shared between tasks. A block diagram of the MC68451 MMU is shown in Figure 2

During normal translation, the MMU translates the logical address provided by the MC68000 to produce a physical address which is then presented to the memory array. This is accomplished by matching the logical address with the information in the Descriptors and then mapping it into the physical address space.

Refer to Figure 1 for the following. The logical address is composed of address lines A1-A23. The upper sixteen bits of this address (A8-A23) are translated by the MMU and mapped into a physical address (PA8-PA23). The lower 7 bits of the logical address (A1-A7) bypass the MMU and become the low-order physical address bits (PA1-PA7).



MMU PIN DESCRIPTION

Throughout this document, active low signals are denoted by a superscript bar. This does not imply logical negation. To avoid confusion, a signal in its true state is said to be asserted whether that signal is active high or low. It is said to be negated when it is in its functionally inactive state. A signal which can be placed in the high-impedance state is said to be three-stated. A signal line which is first driven high and then placed in the high-impedance state is said to be rescinded.

Some MMU signal lines are classed as input/output meaning that the bus buffers can be directed inward to input information into the MMU or outward to drive the bus. These signals must be either inputs or outputs at any given time, they may not be both. An example is the PAD port.

Still other types of signals can logically be both inputs or outputs at the same time. The internal signal controller may assert or negate a signal and read it at the same time. To distinguish between them, the suffix "in" will be used to denote the input signal and the suffix "out" will be used for the output signal.

Six pins on the MMU have this property — IRQ, FAULT, MAS, GO, ANY, and ALL In a multiple-MMU system, they would be wired in parallel to provide a single-signal level for the entire system. Of these, three pins — IRQ, FAULT, and ANY are active low, wire-OR type signals As such, asserting any one of the parallel pins will drive the line low (true). If any of these signals are asserted on any MMU in the system, they will be detected as asserted on the corresponding "in" pin of all MMUs in the system.

The ALL pin is an active-high, open-drain gate and, as such, all pins are wire-ANDed and must be driven high in order for the input to be high. Therefore, even if ALLout is asserted by an MMU, ALLin will not be detected true by any MMU unless all of the corresponding pins on all MMUs in the system are asserted.

The $\overline{\text{GO}}$ and $\overline{\text{MAS}}$ pins are not open drain but they can be put in the high-impedance state. They should each be wired in parallel on all MMUs in the system since only one MMU at any given time will assert these signals. A pullup resistor is required to hold the signal inactive when the pin is in the high-impedance state.

 \mbox{VCC},\mbox{GND} — These pins supply power to the MMU. The two \mbox{VCC} pins are ± 5 volts and the two GND pins are ground

CLOCK — (TTL, input) This signal must be the MC68000 system clock and must not be gated off at any time

 $\begin{array}{c} \textbf{CS} - \text{(Chip-Select, input)} \ \overline{\text{CS}} \ \text{is used to activate the MMU} \\ \text{for accesses to the registers and other MMU operations} \ \ \text{The} \\ \text{assertion of} \ \overline{\text{CS}}, \ \text{in conjunction with the address of a global operation on pins RS1-RS5}, \ \text{selects the MMU to be a 'master'' for that operation} \ \ \overline{\text{CS}} \ \text{should be decoded from the physical address bus to protect the MMU registers from unauthorized access} \ \ \text{See MMU OPERATIONS}. \end{array}$

RS1-RS5 — (Register Selects, inputs) These five pins should be the lower five bits of the physical address bus When \overline{CS} is asserted, these pins select the operation to be performed and the register involved (if any) See Table 3 for the operations address map.

 $R\overline{\mathcal{M}}$ — (Read/Write, input) The $R\overline{\mathcal{M}}$ input signal controls the direction of the data bus during an MMU operation. It is also used to compare against the matched Descriptor to determine if a write violation has occurred during translation

RESET — (Input) Asserting the RESET input will reset the MMU regardless of what state it is in The RESET pin must be held low for at least 16 clock cycles to reset the MMU. During power-up, the RESET pin must be held low for at least 100 milliseconds after V_{CC} is established and the clock signal is present. See RESET STATE

DTACK — (Data Transfer Acknowledge, output, rescindable) The MMU uses this output to signal the completion of the operation phase of a bus cycle to the processor. If the bus cycle is a processor read, the MMU asserts DTACK to indicate that the information on the data bus is valid. If the bus cycle is a processor write to the MMU, DTACK is used to acknowledge acceptance of the data by the MMU DTACK may be asserted only by an MMU that has CS or IACK asserted.

UDS, LDS — (Upper Data Strobe, Lower Data Strobe, Inputs) UDS and LDS are used during MMU operation (procesor access of MMU registers) to indicate which byte of the data bus is to be used. The assertion of the Upper Data Strobe indicates that the operation is to be performed at an even address using the upper byte of the data bus. The assertion of Lower Data Strobe, indicates the use of an odd address and the lower byte of the data bus. During a processor write operation, the data strobes indicate to the MMU that valid data is on the data bus.

AS — (Address Strobe, input) This signal indicates to the MMU that a bus cycle is in progress, and that there is a valid address on the logical address bus. The assertion of AS initiates the normal translation phase of the bus cycle.

PAD0-PAD15 — (Physical Address and Data, multiplexed input/output, three-state) During MMU operations, these 16 pins function as the data bus used to transfer data to and from the MMU During normal translation, the physical address PA8-PA23 is gated out on this bus. External octal data transceivers are used to isolate the system data bus from the physical address bus and the MMU provides the Enable Data (ED) signal to control these transceivers. See the description of the ED signal for more detail.

 $\overline{\text{ED}}$ – (Enable Data, output, three-state) The Enable Data signal is used to control the external bus transceivers on the PAD port. When $\overline{\text{ED}}$ is asserted, the transceivers should be enabled (i.e., they should drive the bus). When $\overline{\text{ED}}$ is negated, the transceivers should be in the high-impedance state. R/\overline{W} is used to control the direction of the transceivers. Only the MMU with $\overline{\text{CS}}$ or $\overline{\text{IACK}}$ asserted will assert $\overline{\text{ED}}$

NOTE

A pair of 74LS245 data transceivers may be used $\overline{\text{ED}}$ will drive the Output Enable pin with no additional logic See the circuit diagram in Figure 7.

HAD – (Hold Address, output, rescindable) HAD is used to control an external latch on the physical address bus After normal translation, HAD is asserted to hold the physical address stable. The latch should be of the transparent type such as a 74LS373 HAD can directly interface with the Enable pin of this type of latch. To provide address hold time, HAD is rescinded after MAS is rescinded.

 \mbox{MODE} – (Input, three-level) The \mbox{MODE} input is used to program the mode of operation of the \mbox{MAS} signal. There are three modes of operation. A, S1, and S2

Mode A is selected by leaving the MODE pin unconnected. Mode S1 is selected by tying MODE to V_{CC} and

MODE S2 is selected by tying the MODE pin to ground. For a description of the different modes, see MAS TIMING MODES in the section on HARDWARE CONSIDERATIONS.

 $\overline{\textbf{IRQ}}$ — (Interrupt Request, input/output, open drain) IRQout is used to request an interrupt of the MPU $\overline{\textbf{IRQ}}$ out is asserted if a Descriptor in which the I (Interrupt) bit is set, is matched in normal translation, and the Interrupt Enable (IE) bit in the Global Status Register (GSR) is set Clearing all IP (Interrupt Pending) bits in all Segment Status Registers or clearing IE in the GSR will cause $\overline{\textbf{IRQ}}$ to be negated If $\overline{\textbf{IRQ}}$ in and $\overline{\textbf{IACK}}$ are asserted, the MMU will perform the interrupt acknowledge operation. See MMU OPERATIONS The $\overline{\textbf{IRQ}}$ lines of all MMUs should be wire-ORed together and tied to VCC through a pullup resistor They should be isolated from the IRQ lines of other devices to prevent an MMU from detecting an erroneous interrupt.

 $\overline{\textbf{IACK}}$ — (Interrupt Acknowedge, input) An MMU will begin the interrupt acknowledge operation if $\overline{\textbf{IRQ}}$ in and $\overline{\textbf{IACK}}$ are both asserted. The interrupt vector supplied by the Interrupt Vector Register (IVR) is placed on the data bus for the MPU. Only one MMU should have its $\overline{\textbf{IACK}}$ pin tied to the IACK circuitry from the processor, all other MMUs should have this pin tied high (inactive).

FAULT — (Input/output, open drain) During normal translation, if an MMU detects a write violation or an undefined segment access, it asserts the FAULT line for 5 clock cycles or until AS becomes negated, whichever is longer If an MMU detects FAULT in asserted, it updates its Global and Local status registers to reflect this. The FAULT lines of all MMUs in the system should be wire-ORed and tied to VCC through a pullup resistor. The FAULT signals can be connected directly to the MC68000 BERR pin but they should be isolated from any other Bus Error signals in the system to prevent the MMUs from detecting an erroneous FAULT. See MULTIPLE MMU SYSTEMS.

FC0-FC3 — (Function Code 0-3, inputs) The Function Code inputs specify the type of bus cycle being executed by the current bus master. The function code indicates which Address Space is to be used for that cycle and is used to index into the Address Space Table for the cycle address space number used in descriptor matching. See FUNCTION CODES and ADDRESS SPACES. The MC68000 MPU and the MC68450 DMAC provide only 3 bits of the function code FC0-FC2. In a system with more than one bus master, the fourth pin could be tied to $\overline{\rm BGACK}$. If the system has only one bus master, FC3 should be tied low.

A8-A23 — (Inputs) These are the upper sixteen bits of the MPU address bus. They form the logical address which the MMU translates into sixteen physical-address bits. The lower seven address lines bypass the MMU.

 $\overline{\text{GO}}$ — (Global Operation, input/output, rescindable) $\overline{\text{GO}}$ is an inter-MMU signal used in multiple-MMU systems to indicate or detect global operations. If $\overline{\text{CS}}$ is asserted and the operation to be performed is global, The MMU is selected as the master for that operation $\overline{\text{GO}}$ out is then asserted by the master MMU to signal other MMUs that they are slaves in a

global operation. Thus, if $\overline{\text{GO}}$ is asserted while $\overline{\text{CS}}$ is negated, the MMU is selected as a slave for that operation. For a detailed description see MMU OPERATIONS

ANY — (Input/output, open drain) They ANY signal is used in inter-MMU handshaking in multiple-MMU systems A slave MMU asserts ANY out during a global operation if it has a local event to report which is significant if it occurs in one, but not necessarily all, MMUs. The ANY pins are wire-ORed and require a pullup resistor to VCC.

ALL — (Input/output, open drain) The ALL pin is similar to ANY except that it reports events that are significant only when they occur in all MMUs. The ALL pins are wire-ANDed together and require a pullup resistor to V_{CC}

MAS — (Mapped Address Strobe, input/output, rescindable) MASout is asserted by an MMU if an address match occurs during normal translation. This indicates that a valid physical address is present at the PADO-PAD15 outputs MAS in is used by an MMU to detect a successful translation by another MMU MAS can be programmed to operate in an asynchronous or synchronous mode by the MODE pin

WIN − (Write Inhibit, output, rescindable) WIN is provided to protect write-protected segments during read/modify/write bus cycles Normally, write-protected segments are protected by the assertion of FAULT and the withholding of MAS upon detection of an attempted write to that segment However, during read/modify/write bus cycles, AS remains asserted, making it difficult to prevent the write portion of the instruction from writing to the protected segment. To provide write protection during these instructions, WIN should be included in the decoding of the

physical data strobes See PHYSICAL DATA STROBES under HARDWARE CONSIDERATIONS WIN is asserted with MAS each time a write-protected segment is accessed, whether the access is a read or a write

NOTE

In multiple-MMU systems, MAS, HAD, WIN, FAULT, DTACK, ED, and GO should be connected in parallel to their respective pins on all MMUs. Each should be tied to VCC through a pullup resistor to insure that the signal is negated while the pin is in the high-impedance state.

MMU REGISTER DESCRIPTION

Figure 3 shows a programmer's model of the MMU. The MMU registers consist of two groups: the Descriptors and the System registers. Each of the 32 Descriptors is nine bytes long and defines one memory segment. See DESCRIPTORS below.

In the following discussion, a segment access is defined as a successful match occurring on a segment during normal translation

The System registers contain both information local to the MMU and information global to the MMM Each bit in the System registers and the Segment Status registers, except the Address Space Table, is one of four types

Control

Control bits can be set or cleared by the MPU to select MMU options. These are

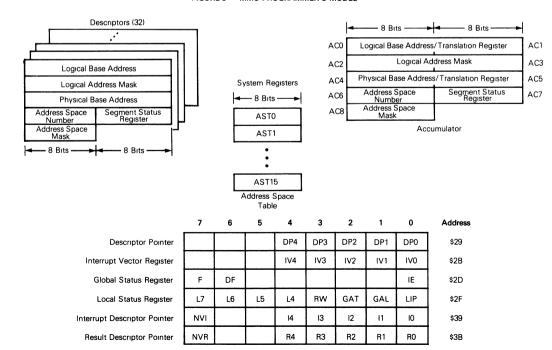
read/write bits

Status Alterable

SA bits are set or cleared by the MMU to indicate status information. These are

also read/write bits

FIGURE 3 - MMU PROGRAMMER'S MODEL



Status Unalterable SU bits are set or cleared by the MMU to

reflect status information. These bits

cannot be written by the MPU

Reserved Reserved bits are reserved for future expansion. They cannot be written and are

zero when read

The System registers are all directly addressable from the physical-address space. Accessing registers causes certain operations to be performed. See OPERATIONS ADDRESS MAP for the locations of System registers. The Descriptors are not directly addressable, but are accessed using the Descriptor Pointer and the Accumulator.

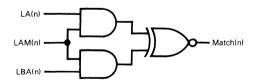
DESCRIPTORS

Each MMU contains 32 Descriptors (0-31), each of which can define one memory segment. A Descriptor is loaded by the MPU using the Accumulator and Discriptor Pointer with a Load Descriptor operation. The Segment Status Register (SSR) can be written to by the MPU indirectly using the Descriptor Pointer. Each Descriptor consists of the following registers.

LOGICAL BASE ADDRESS (LBA) — The LBA is a 16-bit register which, together with the Logical Address Mask (LAM), defines the logical addressing range of a segment This is typically the first address in the segment, although it can be any address within the range defined by the LAM

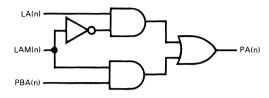
LOGICAL ADDRESS MASK (LAM) — The LAM is a 16-bit mask which defines the bit positions in the LBA which are to be used for range matching. Ones, in the mask, mark significant bit positions while zeroes indicate "don't care" positions. A range match occurs if, in each bit position in the LAM which is set to one, the LBA matches the incoming logical address. The matching function is depicted schematically in Figure 4.

FIGURE 4 — SCHEMATIC LOGIC OF ADDRESS MATCHING
Note LA(n) Indicates Bit N of Logical Address



PHYSICAL BASE ADDRESS (PBA) — The PBA is a 16-bit address which, with the LAM and the incoming logical address, is used to form the physical address. The logical address is passed through to the physical address in those bit positions in the LAM which contain zeroes (the "don't cares") and the PBA is gated out in those positions which contain ones. A schematic representation of the physical address generation mechanism is shown in Figure 5

FIGURE 5 — SCHEMATIC LOGIC OF PHYSICAL ADDRESS GENERATION



ADDRESS SPACE NUMBER (ASN) — The ASN is an 8-bit number which, together with the Address Space Mask, is used in detecting a match with the cycle address space number See ADDRESS SPACE NUMBERS

ADDRESS SPACE MASK (ASM) — The ASM is an 8-bit mask which defines the significant bit positions in the ASN to be used in descriptor matching As in the LAM, the bit positions which are set are used for matching and the bit positions that are clear are "don't cares". A space match occurs if, in the significant bit positions, the cycle address space number matches the ASN Address space matching is schematically similar to logical address matching as shown in Figure 4.

SEGMENT STATUS REGISTER (SSR) — Each Descriptor has an 8-bit SSR. The SSR can be written to in two ways using the Load Descriptor operation or indirectly using the Descriptor Pointer in a Write Status Register operation. Each bit is labeled as control or status alterable. Bits 5 and 6 are reserved for future use.

| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---|---|---|---|----|---|----|---|
| U | | | T | ΙP | М | WP | Ε |

ADDRESS Indirect through Descriptor Pointer

U (Used) is set by the MMU if the segment was accessed since it was defined. This bit is status alterable.

SET

a) by a segment access (successful translation using the segment)

b) by an MPU write of "1"

CLEARED

a) Reset (in segment #0 of Master)

b) MPU write of "0"

If the I (Interrupt) control bit is set, an interrupt is generated upon accessing the segment

SET

a) MPU writes "1"

CLEARED

a) MPU writes "0"

b) Reset (segment #0 of Master)

IP IP (Interrupt Pending) is set if the "I" bit is set when the segment is accessed IRQout is asserted if an IP bit, in one or more SSRs, is set and IE in the Global Status Register (GSR) is set IRQout is negated when all the IP bits in all SSRs are clear or IE is cleared IP is status alterable and should be cleared by the interrupt service routine

SET a) segment access and "I" is set

b) MPU writes "1"

CLEARED a) MPU writes a "0"

b) Reset (in segment #0 of Master)

c) E bit is a "0"

M The M (Modified) bit is set by the MMU if the segment has been written to since it was defined. The M bit is status alterable.

SET a) Successful write to the segment

b) MPU writes a "1"

CLEARED a) MPU writes a "0"

b) Reset (segment #0 in Master)

WP If the WP (Write Protect) control bit is set, the segment is write protected. A write access to the segment with WP set will cause a write violation.

SET a) MPU writes a "1"

CLEARED a) MPU writes a "0"

b) Reset (segment #0 in Master)

E (Enable) is a control bit which, when set, enables the segment to participate in the matching process E can be cleared (the segment disabled) by a write to the SSR, but a Load Descriptor operation must be performd to set it

SET a) Load descriptor with AC7, bit #0

b) Reset (segment #0 in Master)

CLEARED a) MPU writes a "0"

b) Unsuccessful load descriptor operation on this descriptor

 c) Load descriptor operation with AC7, bit #0 clear

SYSTEM REGISTERS

The System Registers consist of the Address Space Table, Accumulator, Global Status Register, Local Status Register, Descriptor Pointer, Result Descriptor Pointer, Interrupt Descriptor Pointer, and Interrupt Vector Register Each of these registers is described below

ADDRESS SPACE TABLE (AST) — Each MMU has a local copy of the AST. This table is organized as sixteen 8-bit, read/write registers located starting at address \$00. Each entry is programmed by the operating system with a unique address space number, each of which is associated with a task. During a memory access, the MMU receives a 4-bit function code (FC0-FC3) which is used to index into the AST to select the cycle address space number. This number is then used to check for a match with the ASN in each of the 32 Segment Descriptors.

The MC68000 MPU and the MC68450 only provide a 3-bit function code, FC0-FC2. In a system with more than one bus master, the $\overline{\text{BGACK}}$ signal from the MPU could be inverted and used as FC3. This would result in the AST organization shown in Figure 6.

FIGURE 6 - ADDRESS SPACE TABLE ORGANIZATION

| | F C 3 | F C 2 | F C 1 | F C 0 | ≪ 8 Bits → | |
|----------|-------------|-------------|-------------|-------------|-------------------|-----------------------|
| 1 | 0 | 0 | 0 | 0 | AST0 | |
| | 0 | 0 | 0 | 1 | AST1 | User Data |
| | 0 | 0 | 1 | 0 | AST2 | User Program |
| | 0 | 0 | 1 | 1 | AST3 | |
| MPU | 0 | 1 | 0 | 0 | AST4 | |
| | 0 | 1 | 0 | 1 | AST5 | Supervisor Data |
| | 0 | 1 | 1 | 0 | AST6 | Supervisor Program |
| <u></u> | 0 | 1 | 1 | 1 | AST7 | Interrupt Acknowledge |
| 1 | 1 | 0 | 0 | 0 | AST8 | |
| | 1 | 0 | 0 | 1 | AST9 | |
| | 1 | 0 | 1 | 0 | AST10 | |
| | 1 | 0 | 1 | 1 | AST11 | |
| DMA | . 1 | 1 | 0 | 0 | AST12 | |
| | 1 | 1 | 0 | 1 | AST13 | |
| | 1 | 1 | 1 | 0 | AST14 | |
| <u> </u> | . 1 | 1 | 1 | 1 | AST15 | |

ACCUMULATOR (ACO-AC8) - The Accumulator (shown in Figure 3) is used to access the Descriptors, perform Direct Translation, and latch information during a fault. The Accumulator consists of nine 8-bit registers. The register assignments for each operation in which it participates is shown in Table 1

The contents of the Accumulator can be either local or global depending on the preceding operations. The GAL and GAT bits in the Local Status Register (LSR) indicate whether the information in the Accumulator is sufficiently global to perform a Load Descriptor or Direct Translation operation

TABLE 1 - ACCUMULATOR ASSIGNMENTS FOR OPERATIONS

| Register Assignment | Load/Read Descriptor | Direct Translation | Normal Translation (FAULT) |
|------------------------|-----------------------------|--------------------------------------|----------------------------|
| AC0 | Logical Base Address (MSB) | Logical Translation Register (MSB) | Logical Address (MSB) |
| AC1 | Logical Base Address (LSB) | Logical Translation Register (LSB) | Logical Address (LSB) |
| AC2 | Logical Address Mask (MSB) | | |
| AC3 | Logical Address Mask (LSB) | | |
| AC4 | Physical Base Address (MSB) | Physical Translation Register (MS13) | |
| AC5 | Pysical Base Address (LSB) | Physical Translation Register (LSB) | |
| AC6 | Address Space Number | Address Space Number | Cycle Address Space Number |
| AC7 | Segment Status | | |
| AC8 | Address Space Mask | | |

GLOBAL STATUS REGISTER (GSR) - The GSR is an 8-bit register used to reflect Faults and to enable interrupts from an MMU All MMUs maintain identical information in their GSRs. Bits 1, 2, 3, 4, and 5 are reversed for future use The organization of the GSR is shown below

ADDRESS DF ΙE \$2D GSR

F (Fault) is a status alterable bit that is set by the MMU whenever FAULTin is detected. Clearing the F. bit automatically clears bits L4-L7 in the Local Status Register

SET

- a) Write violation detected in this MMU
- FAULTin detected (write violation in another MMU)
- c) ALLin detected (Undefined Seqment Access)
- d) MPU writes a "1"

CLEARED

- a) Reset asserted
- b) MPU writes a "0"

DF (Double Fault) is set if a FAULTin signal was DF detected with F set DF is a status alterable bit

SET

- a) FAULTin detected and F was previously set
- b) MPU writes a "1"

CLEARED

- a) Reset
- b) MPU writes a "0"

ΙE If IE (Interrupt Enable) is set, the interrupt-request line is enabled. This is a read/write control bit

SFT

a) MPU writes a "1"

CLEARED

- a) Reset
- b) MPU writes a "0"

LOCAL STATUS REGISTER (LSR) - The LSR is an 8-bit register which reflects information local to its MMU. The LSR can be globally written but the GAL, GAT, and LIP bits will not be affected L4-L7 are cleared if F in the GSR is cleared All bits in the LSR are cleared on reset. The organization of the LSR is shown below.

| | | - | - | | - | | | | ADDRESS |
|-----|----|----|----|----|----|-----|-----|-----|---------|
| LSR | L7 | L6 | L5 | L4 | RW | GAT | GAL | LIP | \$2F |

the R/W pin at the time FAULTin is asserted SET

RW

- RW is a status alterable bit which reflects the state of a) MPU writes a "1"
 - b) Read of segment when F in SSR is set

CLEARED

- a) Reset
- b) MPU writes a "0"
- c) Write of segment when F in SSR is set

GAT (Global Accumulator for Translate) is set by the MMU if ACO, 1, and 6 are globally consistent. See **GLOBAL OPERATIONS**

SET

- a) If ACO, AC1, and AC6 are globally consistent (they were last modified as a result of a global
 - write)
- CLEARED a) Reset
 - b) If ACO, AC1, and AC6 are not globally consistent
- GAL (Global Accumulator for Load) is set if ACO, 1, 2, 3, 6, and 8 are globally consistent
 - SET a) If ACO, AC1, AC2, AC3, AC6, and AC8 are globally consistent

CLEARED

- a) Reset
- b) If ACO, AC1, AC2, AC3, AC6, and AC8 are not globally consistent

LIP LIP (Local Interrupt Pending) is set if one or more Descriptors have IP set in their Segment Status Registers

> SET: a) If IP is set in any Descriptor

CLEARED: a) Reset

b) If all IP bits are clear

L4-L7 The status information encoded in L4-L7 reflects the status of the MMU after the last event (an operation or fault). These bits are encoded and changed as a unit. They are cleared whenever the F bit in the GSR is cleared and are alterable by the MPU.

L7 L6 L5 L4 0 0 0 0 NO The MMU was not the source of the last event. A Direct Translation was locally suc-1 0 0 0 DT cessful. A match was found in one of the MMUs Descriptors. 1 0 0 1 LD A Load Descriptor fault occurred A previously defined Descriptor conflicts with the Descriptor being loaded 1 0 1 0 USA An Undefined Segment Access was attempted. The logical address was not matched in any Descriptor in the MMM A Write Violation occurred A segment 1 0 0 WV defined in this MMU was write protected and a write to that memory segment was attempted. The NVR bit in the RDP will show whether the USA or WV occurred in this MMU See RESULT DESCRIPTOR POINTER.

> SET: a) Various bits set if DT, LD, USA or

WV occur

a) Reset

b) MPU writes a "1"

CLEARED:

b) MPU writes a "0"

c) When F bit in GSR is cleared

d) If MMU was not the source of the last event (NO)

DESCRIPTOR POINTER (DP) - The DP is an 8-bit read/write pointer register located at address \$29. The five low-order bits identify the Descriptor to be used in the Load Descriptor, Read Segment Status (Transfer Descriptor), and Write Segment Status operations. Bits 5, 6, and 7 are reserved

The DP is initialized to \$00 on reset. It can be globally written by the MPU. The DP is loaded by the MMU with the number of the Descriptor matched in a Direct Translation operation to allow a subsequent Transfer Descriptor operation to load the matched Descriptor into the Accumulator. See GLOBAL OPERATIONS and DIRECT TRANSLATION.

RESULT DESCRIPTOR POINTER (RDP) - The RDP is an 8-bit, read-only register that identifies a Descriptor involved in the following events: a Write Violation, a Load Descriptor failure, or a Direct Translation success. The RDP is loaded from a Priority Encoder which determines the highest priority Descriptor involved. For example, in a Load Descriptor operation, more than one Descriptor currently in the MMU may collide with the Descriptor being loaded. Only the number of the highest priority Descriptor will be loaded into the RDP. Descriptor 0 is considered to be the highest priority and 31 is the lowest.

The bit assignments are shown below Bits 5 and 6 are reserved. The RDP is initialized to \$80 on reset

| | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | |
|-----|-----|---|---|----|----|----|----|----|-----------------|
| RDP | NVR | | | R4 | R3 | R2 | R1 | R0 | ADDRESS \$3B |

NVR If no Descriptor is selected by the Priority Encoder when the RDP is loaded, NVR (No Valid Result) is set, otherwise it is cleared. This bit is status unalterable

> SET: a) Reset

b) No result from WV. LD. or DT

CLEARED

a) A WV. LD failure of DT success in

R0-R4 R0-R4 encode the number of the Descriptor selected by the Priority Encoder

INTERRUPT DESCRIPTOR POINTER (IDP) - The IDP is an 8-bit read-only register that is read to determine which Descriptor caused an interrupt Each time it is read, the IDP is loaded from the Priority Encoder with the highest-priority Descriptor which has IP set in its SSR If no Descriptor has IP set, the No Valid Interrupt (NVI) bit is set. See INTER-RUPT ACKNOWLEDGE

The bit assignment is shown below. Bits 5 and 6 are reserved

| | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | ADDRESS |
|-----|-----|---|---|----|----|----|----|----|---------|
| IDP | NVI | | | 14 | 13 | 12 | 11 | 10 | \$39 |

NVI NVI is set if no Descriptor has IP set, otherwise it is cleared

10-14 These bits encode the number of the Descriptor selected by the Priority Encoder

INTERRUPT VECTOR REGISTER (IVR) - The IVR is an 8-bit read/write register containing the interrupt vector. Its contents are put on the data lines, D0-D7, during the interrupt acknowledge operation to provide the processor with a vector number. The IVR is initialized to \$0F (the MC68000) uninitialized-device vector number) on reset

MMU FUNCTIONAL DESCRIPTION MULTIPLE MMU SYSTEMS

The Memory Management Mechanism is comprised of one or more Memory Management Units Each MMU is capable of describing thirty-two segments. If more than thirty-two segments are required in the system, more MMUs can be added to increase the number in 32-segment in-

In order to perform its operations, some of the information in the MMU's registers must be global. That is, it must be duplicated in all the MMUs in the system. For example, the Address Space Table must be global to insure that the Address Space Numbers are common to all MMUs. To allow this, certain operations are defined as global. Any system register that can be written, is written globally. This includes the Accumulator, the Address Space Table, the Descriptor Pointer, the Interrupt Vector Register, the Global Status Register, and the Local Status Register The Result Descriptor Pointer and the Interrupt Descriptor Pointer are read-only and, therefore, are local and not global

The $\overline{\text{ANY}}$, ALL, and $\overline{\text{GO}}$ signal lines are used to connect multiple MMUs to form the MMM. The MMM uses these input/output signals to communicate information between MMUs and maintain functional unity. The $\overline{\text{GO}}$ (Global Operation) pin is used to establish the Master-Slave relationship between MMUs for a given operation. The $\overline{\text{ANY}}$ signal is detected as true if any MMU asserts it, allowing MMUs to report conditions that are important in even one device. The ALL signal is detected as true only if all MMUs assert it. It is used to verify that all MMUs in the system have performed some operation or are in the same state. A sample circuit diagram of a two-MMU system is shown in Figure 7.

During each global operation, one MMU is specified as the Master, all others are designated as Slaves. The MMU which has its Chip Select (\overline{CS}) asserted becomes the Master by asserting the \overline{GO} out signal. This signals the other MMUs that they are Slaves for that operation. Note that all MMUs may be accessed and, therefore, any one may be the Master for a given operation.

MMU FUNCTIONAL STATES

At any time an MMU may be in one of five states. Reset, Idle, Normal Translation, Local Operations, or Global Operations. In a Global Operation, an MMU may be a Master (If \overline{CS} signal is asserted) or a Slave (If \overline{GO} in is asserted). In addition, two actions can occur regardless of the current state

- 1 If RESET is asserted, the Reset operation begins. The MMM will remain in the Reset state until RESET is negated.
- 2 IRQout is asserted if LIP in the LSR and IE in the GSR are set, otherwise it is placed in the high-impedance state and should be negated with a pullup resistor

THE RESET STATE — Asserting RESET will initiate the Reset sequence regardless of the state of the MMU During Reset, GO, DTACK, ED, MAS, HAD, and WIN are rescinded. The PAD port, FAULT, and ANY are placed in the high-impedance state. Pullup resistors on FAULT and ANY keep these signals negated. The ALL pin is driven low to negate it.

The GSR, LSR, DP, and the entire Address Space Table are initialized to \$00. The RDP is initialized to \$80 and the IVR to \$0F. All Descriptors are disabled by clearing the Enable bits in their Segment Status Registers.

In order to allow the address bus to function before the operating system can initialize the MMM, one MMU is selected to have Descriptor #0 initialized so that it maps any logical address unchanged to the physical address bus. The MMU is selected for this by having its chip-select line asserted during Reset. This circuit is shown in the diagram in Figure 7.

Descriptor 0 in the selected MMU will have had its LAM and ASN cleared to \$00, its ASM set to \$FF, and the Enable bit set Because of this, the logical address passes to the physical address bus (via Descriptor #0) without alteration. The Enable bits of Descriptors 1-31 are cleared to zero to disable them and their contents remain uninitialized. If the MMU is not chip selected during Reset, the Enable bits in all Descriptors are cleared and no Descriptor is initialized.

THE IDLE STATE — The Idle state is used to terminate bus accesses and prepare for new ones. The MMU is "backed-off" the bus, i.e., the data tranceivers are placed in

the high-impedance state and the address latches are put into the transparent mode. The outputs are driven to the same levels as in Reset except that \overrightarrow{HAD} is rescinded one-half clock after \overrightarrow{MAS} to provide address hold time

While in the Idle state, the MMU uses the Function Code inputs to index into the AST to provide the Cycle Address Space Number. If \overline{AS} is asserted, a Normal Translation is performed. If \overline{AS} is negated and \overline{CS} , \overline{IACK} , \overline{IRQ} in, \overline{GO} , and the data strobes indicate an access from the physical bus, an operation is performed. For further information, see MMU OPERATIONS

NORMAL ADDRESS TRANSLATION

At the start of a bus cycle, the processor presents the logical address, R/\overline{W} , and the function code to the MMM The function code is used to index into the Address Space Table to select the Cycle Address Space number When \overline{AS} is asserted, the Normal Translation phase begins by sending the Cycle Address Space Number, the logical address, and R/\overline{W} to each Descriptor for matching

Note

The function codes must be valid before \overline{AS} is asserted to allow for the table lookup. Current versions of the MC68000 provide this setup time, however, early masks sets (R9M, T6E) do not. With these early mask sets, \overline{AS} must be delayed to the MMU.

MATCHING — Matches can occur in two areas range and space

A range match occurs if, in each bit position in the LAM which is set, the incoming logical address matches the LBA

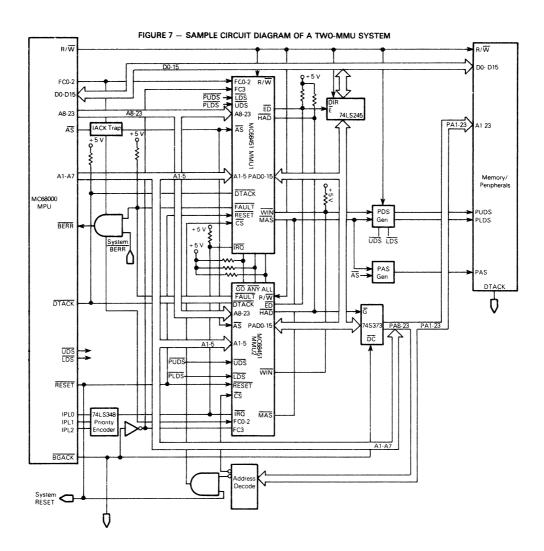
A space match occurs if, in each bit position in the ASM which is set, the cycle address space number matches the ASN

SUCCESSFUL TRANSLATION — An address match occurs if there is a range match and a space match. A write violation occurs if a write is attempted to a write-protected segment. If there is an address match in a Descriptor and no write violation, the physical address is formed from the PBA of that Descriptor and the logical address. The logical address is passed through in those bit positions in the LAM which are clear (the "don't cares"). In the other bit positions the PBA is gated out to the physical address bus

The U and, if the cycle was a write, the M bits in the Segment Status Register are set. If the I bit is set, then the IP bit is set $\overline{\text{WIN}}$ is asserted if the WP bit is set and the cycle was a read or a read/modify/write. If the cycle was a write, $\overline{\text{MAS}}$ is not asserted to prevent the write from modifying data

After the Physical Address is stable, $\overline{\text{MAS}}$ is asserted to indicate a valid address is on the bus $\overline{\text{HAD}}$ is asserted to hold the address stable on the latches and the PAD0-PAD15 lines are then placed in the high-impedance state. If $\overline{\text{AS}}$ is then negated, the cycle has terminated and the MMU returns to the ldle state. If $\overline{\text{AS}}$ is not negated, the cycle can continue in three ways.

- If CS or IACK and IRQ in are asserted, the MMU will begin an operation as a Master See Master Operations
- 2 If GOin is detected by an MMU it will begin a Slave operation. See Slave Operations.



3 If a high-to-low transition is detected on R/W, indicating a write, AS remains asserted and the matched segment is write protected, a write violation occurs. This would be the result of a read/modify/write bus cycle on a protected segment.

WRITE VIOLATION — If an address match occurs but the bus cycle was a write to a write protected segment, a write violation occurs. In this case, the RDP is loaded from the Priority Encoder, F is set in the GSR, and DF is set if F was previously set. The state of the R/ \overline{W} line is latched into the RW bit of the LSR and L4-L7 are encoded to indicate Write Violation (WV). The FAULTout signal is then asserted for five clock cycles or until \overline{AS} is negated, whichever is greater

The logical address is latched into AC0 (MSB) and AC1 (LSB) of the Accumulator (see Table 1). The cycle address space number is latched into AC6. These registers are marked as non-global with respect to the GAT and GAL bits. If the FAULT pin has been connected to the BERR pin on the MC68000, AS will be negated as the MPU begins the Bus Error exception processing. When AS is negated, the MMU will enter the Idle state.

NO ADDRESS MATCH — If none of the Descriptors in a MMU has an address match, that MMU asserts ALLout, and monitors MASin, FAULTin, and ALLin There are then three possibilities

- The access was successfully translated in another MMU See External Translation
- The access caused a write violation in another MMU See External Write Violation
- 3) The access was to a globally undefined segment. See Undefined Segment Access.

EXTERNAL TRANSLATION – If MAS in becomes asserted, the access was successfully translated by another MMU. The MMU negates ALLout and prepares to end the

normal translation phase. The cycle can then continue in one of three ways.

- 1) If $\overline{\text{AS}}$ becomes negated, the MMU returns to the Idle state
- If CS, or TACK and TRQin are asserted, the MMU begins an operation as a Master
- 3) If GOin is detected true, the MMU begins an operation as a Slave

EXTERNAL WRITE VIOLATION — If the FAULT in line is detected true (low), a write violation occurred in another MMU. The detecting MMU then sets the F bit in the GSR and the DF bit if the F bit was already set. R/W is latched into the RW bit of the LSR, and L4-L7 are cleared to show that the violation did not take place in this MMU. The cycle can then continue in one of the three ways described above in EXTERNAL TRANSLATION.

UNDEFINED SEGMENT ACCESS — If ALLin is detected true (high), none of the other MMUs in the system obtained a match, indicating the segment is globally undefined. The MMU sets the F bit in the GSR and the DF bit if F was set previously. R/\overline{W} is latched into the RW bit of the LSR and L4-L7 are encoded to show a USA.

The logical address is latched into the Accumulator, ACO (MSB), and AC1 (LSB) and the cycle address space number is latched into AC6. These registers are marked non-global with respect to the GAL and GAT bits.

All MMUs assert the FAULT line for five clock periods or until \overline{AS} is negated, whichever is longer. To assure the detection of ALLin by all MMUs, ALLout remains asserted for two clock cycles after ALLin is detected true. ALLout is negated before the beginning of the FAULT pulse. When \overline{AS} is negated, the MMM returns to the Idle state.

MMU OPERATIONS

Table 2 shows the operations which can be performed Each operation is initiated by the access of an address given on the Register Select lines RS1-RS5 and the Upper and

TABLE 2 — SUMMARY OF MMU FUNCTIONS AND OPERATIONS

| Function | Summary |
|------------------------|--|
| IDLE | The MMU backs off the bus to prepare for a new access |
| RESET | The MMU is pre-emptively initialized |
| NORMAL TRANSLATION | The MMU attempts to translate an access from the logical address bus |
| OPERATIONS | The MMU is accessed from the logical or physical bus |
| WRITE SYSTEM REGISTERS | An operation to globally write Sysem Registers |
| READ SYSTEM REGISTERS | An operation to read the System Registers |
| WRITE SEGMENT STATUS | The SSR of a Descriptor can be quickly changed using this operation The Enable bit cannot be set using it, however |
| LOAD DESCRIPTOR | With this operation, the contents of the Accumulator are loaded into the Descriptor pointed to by the Descriptor Pointer |
| TRANSFER DESCRIPTOR | This operation transfers the contents of the selected Descriptor into the Accumulator |
| DIRECT TRANSLATION | An operation to globally translate a logical address for the operating system |
| INTERRUPT ACKNOWLEDGE | An operation that supplies a vector number to the MPU in response to IACK $$ |

Lower Data Strobes The access can be from either the logical or physical address bus In a multi-processor system, an external processor could access the MMM from the physical address bus If the access is from the logical address bus, an address translation is first performed. If the access is from the physical address bus, the operation state is entered directly from the Idle state.

The operation phase is always entered with PAD0-PAD15 in the high-impedance state and either (in the case of an operation following a normal translation) one MMU asserting HAD to hold the physical address, or (in the case of an access from the physical bus) the external processor holding the address. If both $\overline{\text{CS}}$ and either $\overline{\text{UDS}}$ or $\overline{\text{LDS}}$ are asserted or $\overline{\text{IACK}}$ and $\overline{\text{IRQin}}$ are asserted, the MMU asserts $\overline{\text{ED}}$ to enable the data transceivers

If \overline{IACK} and \overline{IRQ} in are asserted, an interrupt acknowledge operation is performed. If \overline{CS} and \overline{UDS} or \overline{LDS} are asserted, the MMM determines which operation to perform by decoding RS1-RS5 and R/\overline{W} . These signals tell which register is associated with the operation, which operation to perform, and whether the operation is local or global

After each operation, DTACK is asserted to indicate to the processor that the operation is finished. When the processor negates UDS and LDS, DTACK and ED are rescinded and PAD0-PAD15 are placed in the high-impedance state. If AS is negated, or had been negated since the last normal translation, the MMU enters the Idle state.

After the DTACK handshake, if AS remains asserted and CS and UDS or LDS are asserted, another master operation is performed. If AS remains asserted and GOin and UDS or LDS are asserted, another Slave operation is performed.

OPERATIONS ADDRESS MAP

Table 3 shows the operations address map Each system register has an address at which it can be read or written. In addition, some addresses do not correspond to a register, but rather designate an operation to be performed by reading that location.

The data strobes are logically separate and operations using both are independent. The operation ends when both data strobes are negated

Some addresses are reserved for future expansion. Any access to an unused location will result in a null operation. If the access is a read, the appropriate byte of the data bus is driven high. If the access is a write, no side-effect occurs.

LOCAL OPERATIONS

Some operations, such as reading the status registers affect only one MMU These are called local operations Local operations include Interrupt Acknowledge, Read System Registers, Transfer Descriptor, and Write Segment Status Register

INTERRUPT ACKNOWLEDGE — The Interrupt Acknowledge operation is performed if IACK and IRQin are asserted at the beginning of the operation phase During Interrupt Acknowledge, the contents of the Interrupt Vector Register are placed on D0-D7, to provide the MPU with a vector number

TABLE 3 - REGISTER/OPERATIONS ADDRESS MAP

| Address | | | | <u> </u> | |
|----------------------------|----|-----------|----|------------------------------|---|
| Binary Hex | | Operation | | | |
| RRRRRR SSSSSS 543210 | | R | w | | Register or Operation |
| 000000 | 00 | L | G | AST 0 | (Alternate, FC3 = 0) |
| 000010 | 02 | L, | G | AST1 | (User Data) |
| 000100 | 04 | L | G | AST 2 | (User Program) |
| 000110 | 06 | L | G | AST 3 | (Alternate, FC3=0) |
| 001000 | 08 | L | G | AST 4 | (Alternate, FC3=0) |
| 001010 | 0A | L | G | AST 5 | (Supervisor Data) |
| 001100 | 0C | L | G | AST 6 | (Supervisor Program) |
| 001110 | 0E | L | G | AST 7 | (Interrupt Acknowledge) |
| 010000 | 10 | L | G | AST 8 | (Alternate, FC3 = 1) |
| 010010 | 12 | L | G | AST 9 | (Alternate, FC3 = 1) |
| 010100 | 14 | L | G | AST 10 | (Alternate, FC3 = 1) |
| 010110 | 16 | L | G | AST 11 | (Alternate, FC3 = 1) |
| 011000 | 18 | L | G | AST 12 | (Alternate, FC3 = 1) |
| 011010 | 1A | L | G | AST 13 | (Alternate, FC3 = 1) |
| 011100 | 1C | L | G | AST 14 | (Alternate, FC3 = 1) |
| 011110 | 1E | L | G | AST 15 | (Alternate, FC3 = 1) |
| 100000 | 20 | L | G | AC0 | (LBA/Translation ADDR (MSB)) |
| 100001 | 21 | L | G | AC1 | (LBA/Translation ADDR (LSB)) |
| 100010 | 22 | L | G | AC2 | (LAM (MSB)) |
| 100011 | 23 | L | G | AC3 | (LAM (LSB)) |
| 100100 | 24 | L | G | AC4 | (PBA/Translated ADDR (MSB)) |
| 100101 | 25 | L | G | AC5 | (PBA/Translated ADDR (LSB)) |
| 100110 | 26 | L | G | AC6 | (Address Space Number) |
| 100111 | 27 | -1 | G | AC7 | (Status Register) |
| 101000 | 28 | L | G | AC8 | (Address Space Mask) |
| 101001 | 29 | L | G | DP | (Descriptor Pointer) |
| 101011 | 2B | L | G | IVR | Interrupt Vector Register |
| 101101 | 2D | L | G | GSR | Global Status |
| 101111 | 2F | L | G | LSR | Local Status |
| 110001 | 31 | L | L | SSR | Segment Status and Transfer Descriptor Operation |
| 111001 | 39 | 31 | LN | IDP | Interrupt Description Ptr |
| 111011 | 3B | L | LN | RDP | Result Descriptor Ptr |
| 111101 | 3D | G | LN | Direct Translation Operation | |
| 111111 3F | | G | LN | Load Descriptor Operation | |
| {Otherwise} | | LN | LN | Null Operation | |

L Local G Global N Null Operation

*RS0 is an internal signal
If UDS = 0 and LDS = 1 → RS0 = 0

If $\overline{UDS} = 1$ and $\overline{LDS} = 0 \rightarrow RS0 = 1$

If $\overline{UDS} = 0$ and $\overline{LDS} = 0 \longrightarrow RSO = X$ If $\overline{UDS} = 1$ and $\overline{LDS} = 1 \longrightarrow RSO = X$

READ SYSTEM REGISTER — Each system register has an address at which it can be read. Each MMU should be chip selected at a different location to access the registers in each. During a processor read of the IDP, the IDP is first loaded from the Priority Encoder and then gated onto D0-D7.

TRANSFER DESCRIPTOR — In order to read the contents of a Descriptor, it must be transferred into the Accumulator and read from there. The Descriptor Pointer is first written by the processor with the number of the Descriptor desired. The Transfer Descriptor operation is then performed by reading from the SSR address (\$31).

The contents of the selected Descriptor is then transferred into the Accumulator as shown in Table 1 and the contents of the SSR are gated onto D0-D7. The Descriptor registers may then be read from the Accumulator.

WRITE SEGMENT STATUS REGISTER — The SSR of any Descriptor can be written using Descriptor Pointer (DP) as a pointer. Any bit may be written except the E bit. Enable may be cleared using this operation but it may not be set

GLOBAL OPERATIONS

A global operation is one which is performed in parallel on all MMUs in the system Global operations include all writes to system registers, the Load Descriptor, Operation, and Direct Translation in global operation, one MMU must be the Master and the rest must be Slaves. The operation begins with $\overline{\text{CS}}$ and $\overline{\text{UDS}}$ or $\overline{\text{LDS}}$ asserted on one MMU. The MMU with $\overline{\text{CS}}$ asserted becomes the Master for that operation. The Master asserts $\overline{\text{GO}}$ out and, upon detecting $\overline{\text{GO}}$ in as true, the other MMUs become Slaves in the operation Global operations include. Global Write System Registers, Load Descriptor, and Direct Translation

If there is only one MMU present in the system, the \overline{ANY} , ALL, and \overline{GO} pins must be negated by tying them to the proper voltages through resistors Global operations then become local only

WRITE SYSTEM REGISTER — Each system register that can be written to is written globally. This includes ACO-AC8, ASTO-AST15, DP, IVR, GSR, and LSR. The operation is performed by writing to the desired register's address

The MMU which has \overline{CS} asserted becomes the Master by asserted \overline{GO} out. The other MMUs detect \overline{GO} in and become Slaves. Each MMU transfers the data on the data bus to the selected register. If the write is to a byte of the Accumulator, that register is marked as global. If F is cleared in the GSR, L4-L7 are also cleared.

When the transfer is completed in each MMU, each will assert ALLout After all MMUs have asserted ALLout, ALLin will be true and, upon detecting ALLin, the Master rescinds $\overline{\text{GO}}$

LOAD DESCRIPTOR OPERATION — Descriptors are loaded by transferring the contents of the Accumulator to the Descriptor after performing global checks for collision A collision exists when two or more enabled Descriptors are programmed to translate the same logical address

To prepare for Descriptor loading, the Accumulator must be loaded globally with the LBA, LAM, ASN, and ASM as described in ACCUMULATOR. To make global collision checks, ACO, AC1, AC2, AC3, AC6, and AC8 must have been globally loaded. If they are, the Global Accumulator for Load (GAL) bit in the LSR of each MMU is set. To initiate the operation, a read from the address \$3F is done. If the load is successful, the data bus will be set to \$00. If a collision is found, the load is unsuccessful and the data bus is set to \$FF.

During the Load Descriptor operation, the MMU with $\overline{\text{CS}}$ asserted becomes the Master by asserting GOout The other MMUs detect $\overline{\text{GO}}$ in and become Slaves The Slave MMUs

decode the operation from RS1-RS5, R/\overline{W} , and the data strobes (\overline{UDS} , \overline{LDS}). The Descriptor whose number is in the Descriptor Pointer is disabled (its E bit is cleared) so that it cannot cause a collision

If the GAL bit in the GSR of a Slave is clear, LA4-LA7 is encoded to indicate LD and $\overline{\text{ANY}}$ out is asserted. If GAL is set, the Slave checks the enabled Descriptors against its Accumulator for collisions. If a conflict is found, the Slave asserts $\overline{\text{ANY}}$ out and loads its RDP with the number of the Descriptor which caused the collision if no collision is detected, L4-L7 are cleared. When Goin is detected, ALLout, and $\overline{\text{ANY}}$ out are negated and the operation ends

The Master aborts the transfer if there is a local Descriptor conflict, if the GAL bit is clear, or if \overline{ANY} in is asserted. If the failure was not local, L4-L7 are cleared. Otherwise, L4-L7 are encoded with LD and ANYout is asserted by the Master. The Master then puts \$FF on D0-D7 to indicate failure to the MPU, negates ALLout and \overline{ANY} out, and rescinds \overline{GO} out When \overline{ANY} in is negated, the operation is terminated.

If there were no local collisions, its GAL bit was set, and ALLin is asserted, the Master completes the transfer and enables the loaded Descriptor. It then puts \$00 on D0-D7 to indicate success, clears L4-L7, negates ALLout, and rescinds $\overline{\text{GO}}$ out

DIRECT TRANSLATION — The Memory Management Mechanism can be used to directly translate the logical address into a physical address and make it available to the processor in the Accumulator The logical address to be translated is globally loaded into AC0-AC1 and the ASN to be used is loaded into AC6. Translation is initiated with a read from the address \$3D.

If the translation is successful, the DP and RDP point to the Descriptor which performed the translation and the Physical address is loaded into AC4-AC5. The processor reads \$00 from the data bus

If the logical address could not be translated because it was globally undefined, the data bus is set to \$FF to indicate the failure

Using AC6 to supply the cycle address space number, each MMU attempts to match the logical address contained in AC0-AC1 with one of its enabled Descriptors Each MMU must have the same information in AC0, AC1 and AC6 The GAT (Global Accumulator for Translation) bit in the LSR is set if these registers have each been globally loaded

If a match is found, and GAT is set, the physical address is formed as in normal translation and put into AC4-AC5. The RDP and DP are loaded from the Priority Encoder and L4-L7 are encoded to indicate Direct Translation (DT). The Master puts \$00 on D0-D7 to signal that the translation was successful, and rescinds $\overline{60}$ to terminate the operation

If no match is found, or GAT is clear, the MMU asserts ALLout and <u>L4-L7</u> in the LSR are cleared. The Master monit<u>ors the \overline{ANY} in and ALLin inputs</u>

If $\overline{\text{ANY}}$ in becomes asserted, then another MMU performed the translation. The Master puts \$00 on D0-D7 to indicate success negates ALLout and rescinds $\overline{\text{GO}}$ out. It waits until $\overline{\text{ANY}}$ in is negated before terminating the operation

If ALLın becomes asserted, then none of the MMUs performed the translation. The Master puts \$FF on D0-D7 to indicate failure, negates ALLout, and rescinds \overline{GO} to terminate the operation. Each Slave MMU negates \overline{ANY} out and ALLout when the Master MMU rescinds \overline{GO} at the end of the operation.

HARDWARE CONSIDERATIONS

MAS TIMING MODES AND PHYSICAL ADDRESS STROBES

The Mapped Address Strobe signals that a valid translated address is present on the physical address bus. It should be included in the generation of the Physical Address Strobe (PAS) which is then used to gate the memory decode circuitry \overline{AS} is also included in the PAS to effect a quick release of the bus at the end of a cycle

MAS can be programmed with the MODE pin in three modes

Mode A $\overline{\text{MAS}}$ is asserted asynchronously $\overline{\text{MAS}}$ is asserted as soon as a match for the function code and logical address is found. A circuit to generate PAS with $\overline{\text{MAS}}$ in Mode A is shown in Figure 8a. The delay of $\overline{\text{AS}}$ should be the delay introduced by the MMU plus the desired setup time for the memory. This allows the user to fine-tune the bus speed for maximum efficiency. The delay can be implemented with delay lines or a clocked flip-flop

Mode S1 MAS is asserted on the first rising edge of CLOCK after the physical address is valid. This mode was intended to allow the generation of PAS by ORing AS and MAS MAS asserts PAS and AS negates it to release the bus quickly at the end of the cy-

cle A circuit to generate PAS using MAS in mode S1 or S2 is shown in Figure 8b

Mode S2 MAS is asserted on the first falling edge of CLOCK after the address is valid. This mode was intended to allow the generation of PAS using \overline{AS} and \overline{MAS} only. A circuit to do this is shown in Figure 8.

PHYSICAL DATA STROBES

The physical data strobes, Physical Upper Data Strobe (PUDS), and Physical Lower Data Strobe (PLDS) should be generated using $\overline{\text{UDS}}$ or $\overline{\text{LDS}}$ gated with MAS and R/\overline{W} This will hold off the strobes until the physical address is valid and protect write-protected memory during read/modify/write cycles (see $\overline{\text{WIN}})$ A circuit to generate the $\overline{\text{PUDS}}$ and $\overline{\text{PLDS}}$ is shown in Figure 9

INTERRUPTS

When the MC68000 responds to an interrupt, it places the Interrupt Acknowledge (IACK) function code on FC0-FC2 and the level of the interrupt to which it is responding on the address lines A1-A3. This is not a true memory access, but the MMU must translate it since $\overline{\rm AS}$ is asserted. To prevent the MMU from attempting to match an address during an interrupt acknowledge cycle, IACK should be decoded from the function code lines and used to disable $\overline{\rm AS}$ to the MMU. A circuit to accomplish this is shown in Figure 10.

FIGURE 8 - PHYSICAL ADDRESS STROBE GENERATION

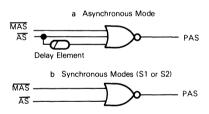
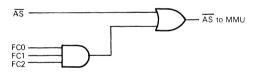
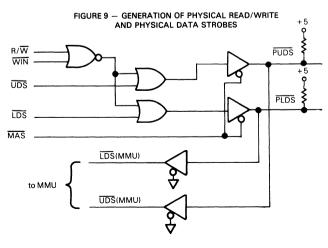


FIGURE 10 - CIRCUIT TO HOLD OFF AS DURING IACK





SOFTWARE CONSIDERATIONS

SEGMENT MAPPING EXAMPLE

In constructing segments, the size of a given segment is determined by the Logical Address Mask. Although there are no constraints on which bits are significant, one approach is to allow only contiguous, low order zeroes ("don't cares"). With this constraint, if there are N zeroes, the size of the segment is 2(8+N) bytes. Since the seven low-order address lines bypass the MMU, the smallest possible segment is 128 words (256 bytes).

In the logical address space, a segment defined this way extends from the address formed by the LBA with zeroes in the "don't care" positions in the LAM to the address formed

the LBA with ones in the "don't care" bit positions. In the physical address space, the segment extends from the address formed by the PBA with zeroes in the "don't care" bit positions in the LAM to the address formed with ones in the "don't care" positions.

Figure 11 shows an example memory map In this example, the map has been divided between two users and the operating system. The user tasks each have three segments A, B, and C. The operating system also has three segments O, V, and R.

FIGURE 11 - ADDRESS MAP EXAMPLE

| Segment | R | > | 0 | 1A | 1B | 2C | 2A | 2B | 2C |
|-----------------------------|------|------|------|------|------|------|------|------|------|
| Logical Base Address (LBA) | 0000 | 8000 | F000 | 0000 | 7FFF | 9000 | 0000 | 7FFF | A000 |
| Logical Address Mask (LAM) | 0000 | FFFC | F000 | E000 | C000 | F000 | F000 | E000 | F000 |
| Physical Base Address (PBA) | 0000 | 0000 | F000 | 2000 | BFFF | E000 | 1000 | 7FFF | E000 |
| Address Space Number (ASN) | FF | 80 | 80 | 01 | 01 | 01 | 02 | 02 | 02 |
| Address Space Mask (ASM) | FF | 80 | 80 | 7F | 7F | 7F | 7F | 7F | 7F |

Segment R maps the logical addresses unchanged to the physical address space, but only for Address Space Number \$00. This segment is automatically generated in Descriptor zero in the Master MMU on Reset. Segments O and V also belong to the operating system and are accessed only by ASNs with bit 7 set. This is an arbitrary assignment and need not be followed.

Segments 1A, 1B, and 1C belong to user number one, and are accessed by address space numbers \$01 and \$81 User 1 would be assigned ANS \$01 and the operating system would use \$81 to access those segments. A parallel situation exists with user 2

Note that segments 1A and 2A are isolated from each other even though they share the same logical addresses User 1 is prevented from accessing the same memory as user 2 because his ASN does not match segment 2A. Segments can overlap in physical memory, however, as 1C and 2C do here.

Note the manner in which segments 1B and 2B are defined. Here the logical and physical base addresses are considered to be the top of the segment rather than the bottom. This is useful in describing push-down, pop-up stacks which grow towards low memory. The same segment can be described in the other way, also. An alternate Descriptor for segment 1B is given below.

| Descriptor | 1B |
|-----------------------|--------|
| Logical Base Address | \$4000 |
| Logical Address Mask | \$C000 |
| Physical Base Address | \$8000 |
| Address Space Number | \$01 |
| Address Space Mask | \$7F |

SEGMENTATION

Since segment sizes must be multiples of two, multiple Descriptors can be used to map a segment of non-binary size For example, a segment of 70K bytes could be constructed using two Descriptors one of 64K bytes and one of 8K bytes, losing 2K bytes to internal fragmentation A purely binary system would allocate 128K bytes, wasting 58K bytes

PAGING

If each segment is the same size, a paged system could be implemented. The Used and Modified bits in the Segment Status Registers allow a variety of placement algorithms and the use of virtual memory.

The MMM supports virtual processing. The 16 bits of the logical address, the cycle address space number, and R/\overline{W}

are latched during a FAULT to provide enough information for an auxiliary processor to fix a page fault

INITIALIZATION SOFTWARE

After a Reset (power-on or processor initiated), the Master MMU (the MMU for which \overline{CS} was asserted during Reset) will map the logical addresses unchanged into the physical address space using Descriptor 0 (see RESET). This will allow the processor to fetch its Supervisor Stack and Program Counter (if it was a power-on Reset) and begin executing the operating system initialization routine. See the MC68000 Advance Information Data Sheet for more information

The operating system would then set up Descriptors for itself and system resources (such as the MMU). The enable a Descriptor, the operating system loads the Descriptor number in the DP register, and the LBA, LAM, PBA, ASN, and ASM into the Accumulator as described in LOAD DESCRIPTOR.

The processor then reads from the appropriate physical address to begin the loading operation. The MMM globally checks for conflicts and loads and enables the Descriptor if none are found. As a result of the read, the processor gets a status byte in the low byte of the word. The status will read \$00 if the load was successful and \$FF if there was a conflict of a conflict occurred, the RDP can be used to find the highest priority conflicting Descriptor.

A Descriptor can be quickly disabled by writing to its Segment Status Register. The I and WP bits can be programmed and the U and M bits can be cleared but the E bit can only be set by a Load Descriptor operation.

Descriptors would then be set up for the user tasks and a task would be selected to execute. Address Space Table enries AST1 and AST2 would then be loaded with the Address Space Number of the task to be run. These are the address spaces of User Data and User Program in the MC68000. The Program Counter and Status Register to be used by the task are then pushed onto the system stack. The processor then executes an RTE instruction which fetches the Status register and program counter off of the stack. The Status Register should have had the supervisor state bit cleared so that the processor will enter the user state and its accesses are then mapped through AST1 and AST2 to start the user task.

To return to the operating system from a user task, a watchdog timer could be used to interrupt the processor. The exception processing caused by this would switch the processor to the supervisor state and the supervisor address spaces would be mapped by the operating systems Descriptors.

CONTEXT SWITCHING

Switching the MMU from one user task to the other is very efficient. Suppose two user tasks were present in memory and the processor had returned to the operating system as described above. To switch tasks, the operating system would change AST1 and AST2 to the ASN of the user task which it wished to execute. It would then push the new Status Register and Program counter on the stack and execute an RTE.

Switching between two supervisor tasks is more complex If AST5 and AST6 are changed while the processor is in the supervisor state, subsequent accesses are immediately mapped through the new address space A Move Multiple

(MOVEM) using the predecrement mode followed by an illegal instruction can be executed to perform the switch. The processor fetches the MOVEM and the illegal instruction, alters AST6 and AST5 (data entry last), then traps through the illegal instruction routine to the new supervisor task. A flag (possibly the illegal instruction opcode) is used to distinguish between normal illegal instructions and attempts to switch tasks in this manner.

Another method is to have a task in the user space perform the switch. The Supervisor Stack Pointer is set up, the processor alerts the Status Register to put itself in the User state, AST5 and AST6 are changed, and the processor traps to the supervisor task.



GENERAL PURPOSE INTERFACE ADAPTER

The MC68488 GPIA provides the means to interface between the IEEE-488 standard instrument bus and the M6800 MPU Family The GPIB instrument bus provides a means of controlling and moving data between instruments connected to it.

The MC68488 will automatically handle all handshake protocol needed on the instrument bus.

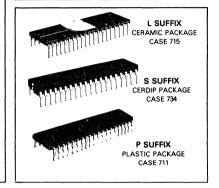
- Single- or Dual-Primary Address Recognition
- Secondary Address Capability (Talker or Listener)
- Complete Source and Acceptor Handshakes
- Programmable Interrupts
- RFD Holdoff to Prevent Data Overrun
- Operates with DMA Controller
- Serial- and Parallel-Polling Capability
- Talk-Only or Listen-Only Capability
- Selectable Automatic Features to Minimize Software
- Synchronization Trigger Output
- M6800 Bus Compatible

MC68488 (1.0 MHz) MC68A488 (1.5 MHz) MC68B488 (2.0 MHz)

MOS

(N-CHANNEL, SILICON-GATE DEPLETION LOAD)

GENERAL PURPOSE INTERFACE ADAPTER



MAXIMUM RATINGS

| Rating | Symbol | Value | Unit |
|-----------------------------|------------------|---------------|------|
| Supply Voltage | Vcc | -0.3 to +70 | ٧ |
| Input Voltage | V _{in} | -03 to +70 | V |
| Operating Temperature Range | TA | 0 to +70 | °C |
| Storage Temperature Range | T _{stg} | - 55 to + 150 | °C |

THERMAL CHARACTERISTICS

| Characteristics | Symbol | Value | Rating |
|--------------------|--------|-------|--------|
| Thermal Resistance | | 1 | |
| Ceramic | | 50 | 00/14/ |
| Cerdip | θJA | 60 | °C/W |
| Plastic | | 100 | |

This device contains circuitry to protect the inputs against damage due to high static voltages or electric fields; however, it is advised that normal precautions be taken to avoid application of any voltage higher than maximum rated voltages to this high-impedance circuit. Reliability of operation is enhanced if unused inputs are tied to an appropriate logic voltage (e.g., either VSS or VCC)

FIGURE 1 - PIN ASIGNMENT

| ۷ss ۱ | 1 ● | 40 T TRQ |
|-------------------|-----|-----------|
| DMA Grant | 2 | 39 7 RS2 |
| cs [| 3 | 38 RS1 |
| ASE [| 4 | 37 RS0 |
| R/₩ [| 5 | 36 J IBO |
| E [| 6 | 35 🕽 IB1 |
| DB0 [| 7 | 34 1 ĪB2 |
| DB1 [| 8 | 33 🕽 ĪB3 |
| DB2 | 9 | 32 T IB4 |
| DB3 [| 10 | 31 🛘 IB5 |
| DB4 [| 11 | 30 T IB6 |
| DB5 | 12 | 29 T IB7 |
| DB6 [| 13 | 28 T/R1 |
| DB7 [| 14 | 27 1 T/R2 |
| DMA Request | 15 | 26 ATN |
| DAV | 16 | 25 I EOI |
| DAC [| 17 | 24 TRIG |
| RFD | 18 | 23 SRQ |
| RESET [| 19 | 22 REN |
| v _{cc} [| 20 | 21 FC |
| | | |

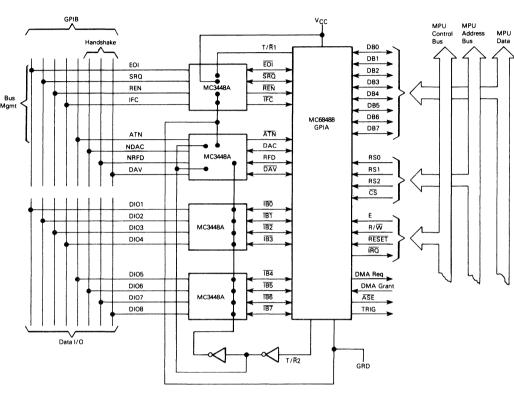


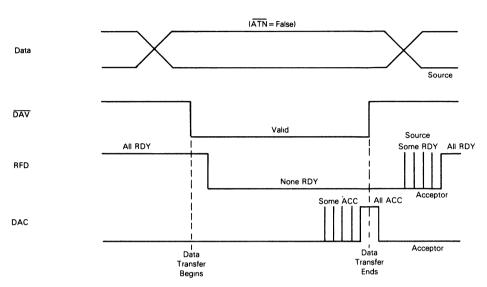
FIGURE 2 - GPIB INTERFACE

Note The four MC3448A quad bus transceivers can be replaced by two MC3447 octal bus transceivers

DC ELECTRICAL CHARACTERISTICS ($V_{CC} = 5.0 \text{ Vdc } \pm 5\%$, $V_{SS} = 0$, $T_A = 0$ to 70°C unless otherwise noted)

| Characteristic | Symbol | Min | Тур | Max | Unit | |
|--|------------|-----------------|----------------------|-----|---------------------|----|
| Input High Voltage | | VIH | V _{SS} + 20 | - | Vcc | ٧ |
| Input Low Voltage | | VIL | V _{SS} -03 | _ | V _{SS} +08 | ٧ |
| Input Leakage Current (V _{In} = 0 to 5 25 V) | | l _{in} | - | 10 | 2 5 | μΑ |
| Three State (Off State) Input Current (V _{IN} = 0 4 to 2 4 V) | D0-D7 | ITSI | - | 20 | 10 | μΑ |
| DC Output High Voltage ($I_{load} = -205 \mu A$) | D0-D7 | Voн | V _{SS} +24 | - | - | ٧ |
| DC Output Low Voltage | | | | | | |
| (I _{Load} = 1 6 mA) | D0-D7 | VOL | _ | - | V _{SS} +04 | ٧ |
| (I _{Load} = 3 2 mA) | SRQ, IPQ | | _ | _ | V _{SS} +04 | |
| Output Leakage Current (Off State) (VOH = 2 4 V) | SRQ, IRQ | ILOH | - | 10 | 10 | μΑ |
| Internal Power Dissipation | | PINT | | 600 | 750 | mW |
| Input Capacitance | | | | | | |
| $(V_{ID} = 0, T_A = 25^{\circ}C, f = 1.0 \text{ MHz})$ | D0-D7 | C _{in} | - | - | 12 5 | pF |
| | All Others | | - | - | 75 | |

FIGURE 3 - SOURCE AND ACCEPTOR HANDSHAKE



This diagram displays logical voltage levels on the MC68488 pins. The MC68488 pins are labeled as the complement of the specified 488 bus callout, i.e., $\overline{\text{DAV}}$ rather than DAV. RFD rather than NRFD and DAC rather than NDAC. This was done to stay with standard positive logic format, which is used with all M6800 family devices

POWER CONSIDERATIONS

The average chip-junction temperature, T_J , in ${}^{\circ}C$ can be obtained from:

$$T_{J} = T_{A} + (P_{D} \bullet \theta_{JA})$$
Where · (1)

T_A ≡ Ambient Temperature, °C

 θ JA = Package Thermal Resistance, Junction-to-Ambient, °C/W

PD = PINT + PPORT

PINT≡ICC×VCC, Watts - Chip Internal Power

PPORT≡Port Power Dissipation, Watts - User Determined

For most applications PPORT ◀PINT and can be neglected. PPORT may become significant if the device is configured to drive Darlington bases or sink LED loads.

An approximate relationship between PD and TJ (if PPORT is neglected) is.

$$P_D = K + (T_J + 273 ^{\circ}C)$$
 (2)

Solving equations 1 and 2 for K gives:

$$K = PD \bullet (T_{\Delta} + 273 \circ C) + \theta_{\perp} \Delta \bullet PD^{2}$$
(3)

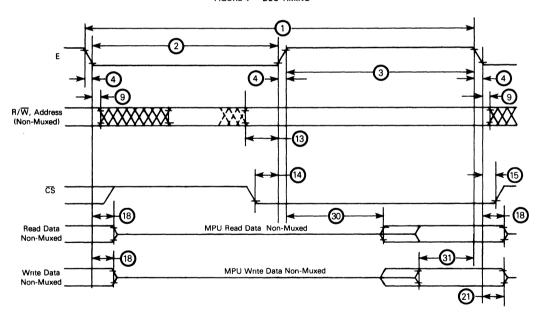
Where K is a constant pertaining to the particular part. K can be determined from equation 3 by measuring PD (at equilibrium) for a known TA. Using this value of K the values of PD and TJ can be obtained by solving equations (1) and (2) iteratively for any value of TA.

BUS TIMING (See Notes 1, 2, and 3)

| ldent. | Characteristics | Symbol | MC68488 | | MC68A488* | | * MC68B488* | | Unit |
|--------|---------------------------------|---------------------------------|---------|------|-----------|------|-------------|------|------|
| Number | Characteristics | Зуппон | Min | Max | Min | Max | Min | Max | Onit |
| 1 | Cycle Time | t _{cyc} | 10 | 10 | 0 67 | 10 | 05 | 10 | μS |
| 2 | Pulse Width, E Low | PWEL | 430 | 9500 | 280 | 9500 | 210 | 9500 | ns |
| 3 | Pulse Width, E High | PWEH | 450 | 9500 | 280 | 9500 | 220 | 9500 | ns |
| 4 | Clock Rise and Fall Time | t _r , t _f | _ | 25 | _ | 25 | - | 20 | ns |
| 9 | Address Hold Time | tAH | 10 | - | 10 | - | 10 | _ | ns |
| 13 | Address Setup Time Before E | tAS | 80 | | 60 | - | 40 | _ | ns |
| 14 | Chip Select Setup Time Before E | tcs | 80 | - | 60 | - | 40 | - | ns |
| 15 | Chip Select Hold Time | tCH | 10 | - | 10 | - | 10 | - | ns |
| 18 | Read Data Hold Time | ^t DHR | 20 | 50** | 20 | 50** | 20 | 50** | ns |
| 21 | Write Data Hold Time | tDHW | 10 | _ | 10 | _ | 10 | _ | ns |
| 30 | Output Data Delay Time | ^t DDR | - | 290 | _ | 180 | - | 150 | ns |
| 31 | Input Data Setup Time | tDSW | 165 | - | 80 | - | 60 | - | ns |

^{*}See Table 1 for GPIB transceiver considerations when using MC68A488 or MC68B488

FIGURE 4 - BUS TIMING



NOTES

- 1. Not all signals are applicable to every part.
- 2 Voltage levels shown are V_L≤0.8 V, V_H≥2.4 V, unless otherwise specified 3. Measurement points shown are 0.8 V and 2.0 V, unless otherwise specified

^{**}The data bus output buffers are no longer sourcing or sinking current by tDHR maximum (high-impedance)

FIGURE 5 - OUTPUT BUS TIMING

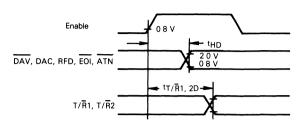


TABLE 1 - AC TIME VALUES

| Characteristics | | Symbol* | Тур | Unit |
|------------------------------------|--------------|----------------|-------|------|
| Settling Time for Multiple Message | SH | T ₁ | ≥2 | μs** |
| Response to ATN | SH, AH, T, L | t3 | ≤200 | ns |
| Interface Message Accept Time‡ | AH | Тз | >0 | § |
| Response to IFC or REN False | T, TE, L, LE | t4 | < 100 | μS |
| Response to ATN•EOI | PP | t5 | ≤200 | ns |

- Time values specified by a lower case t indicate the maximum time allowed to make a state transition. Time values specified by an upper
 case T indicate the minimum time that a funcion must remain in a state before exiting.
- ** If three-state drivers are used on the $\overline{\text{DIO}}\text{-}\overline{\text{DAV}}$ and $\overline{\text{EOI}}$ lines, T₁ may be
 - (1) ≥ 1100 ns
 - (2) Or ≥700 ns if it is known that within the controller ATN is driven by a three-state driver
 - (3) Or ≥500 ns for all subsequent bytes following the first sent after each false transition of ATN [the first byte must be sent in accordance with (1) or (2)]
- ‡ Time required for interface functions to accept, not necessarily respond to interface messages
- § Implementation dependent

When using an E clock of 1 5 MHz on the MC68A488, the GPIB data lines, \overline{DAV} , and \overline{EOI} lines must have three-state drivers — See Note ** When using an E clock of 2 0 MHz on the MC68B488 the GPIB data lines, \overline{DAV} , \overline{EOI} , and \overline{ATN} lines must have three-state drivers — See Note **

GENERAL DESCRIPTION

The IEEE-488 instrument bus standard is a bit-parallel, byte-serial bus structure designed for communication to and from intelligent instruments. Using this standard, many instruments may be interconnected, remotely and automatically controlled, or programmed Data may be taken from, sent to, or transferred between instruments. A bus controller dictates the role of each device by making the attention line true and sending talk or listen addresses on the instrument bus data lines; those devices which have matching addresses are activated. Device addresses are set into each GPIA from switches or jumpers on a PC board by a microprocessor as a part of the initialization sequence.

When the controller makes the attention line true, instrument bus commands may also be sent to single or multiple GPIAs

Information is transmitted on the instrument bus data lines under sequential control of the three handshake lines. No

step in the sequence can be initiated until the previous step is completed. Information transfer can proceed as fast as the devices can respond, but no faster than the slowest device presently addressed as active. This permits several devices of different speeds to receive the same data concurrently.

The GPIA is designed to work with standard 488-bus driver ICs (MC3447As or MC3448As) to meet the complete electrical specifications of the IEEE-488 bus. Additionally, a powered-off instrument may be powered-on without disturbing the 488 bus. With some additional logic, the GPIA could be used with other microprocessors.

The MC68488 GPIA has been designed to interface between the M6800 family microprocessor and the complex protocol of the IEEE-488 instrument bus. Many instrument bus protocol functions are handled automatically by the GPIA and require no additional MPU action. Other functions require minimum MPU response due to a large number of internal registers conveying information on the state of the GPIA and the instrument bus.

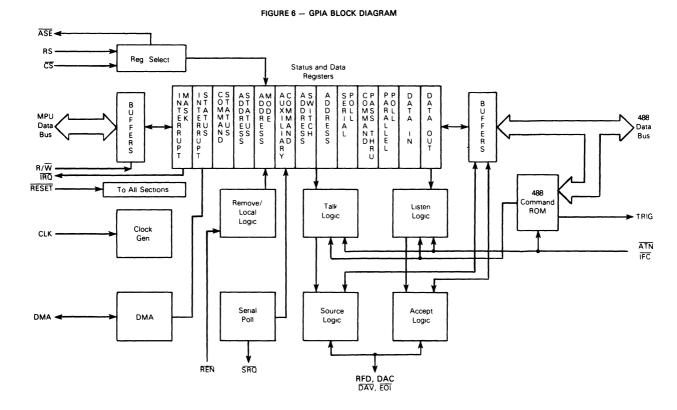
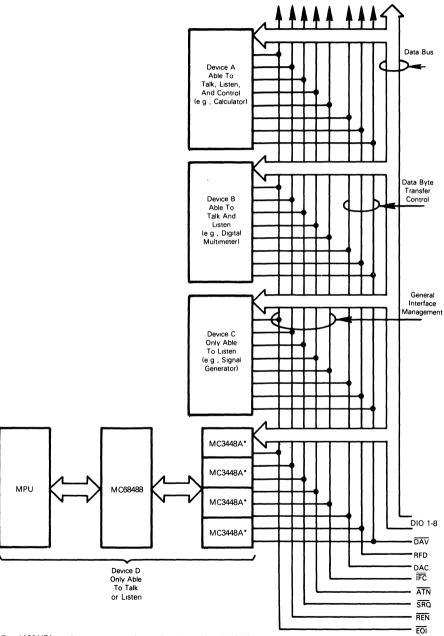


FIGURE 7 - GPIB SYSTEM



^{*}Two MC3447A octal transceivers can be used in place of four MC3448As

PIN DESCRIPTION

All inputs to the GPIA are high impedance and TTL compatible. All outputs from the GPIA are compatible with standard TTL. \overline{IRQ} (Interrupt Request) and \overline{SRQ} , however, are open-drain outputs (no internal pullup).

INTERFACE WITH MPU

BIDIRECTIONAL DATA (D0-D7) — The bidirectional data lines allow the transfer of data between the MPU and GPIA. The data bus output drivers are three-state devices that remain in the high-impedance (off) state except when the MPU performs a GPIA read operation or the DMA controller performs a memory write operation. The Read/Write line is high when the GPIA is selected for a read operation.

CHIP SELECT (CS) — This input signal is used to select the GPIA. CS must be low for selection of the device. Chip Select decoding is normally accomplished with external logic.

READ/WRITE INPUT (R/W) — This signal is generated by the MPU or DMA controller to control register access and direction of data transfer on the data bus. A low state on the GPIA Read/Write and DMA Grant lines allows for the selection of one of seven write-only reigsters when used in conjunction with register select lines RSO, RS1, and RS2. A high state on the GPIA Read/Write and low state on the DMA Grant line allows for the selection of one of eight read-only registers when used in conjunction with register select lines RS0. RS1, and RS2.

REGISTER SELECT (RS0, RS1, RS2) — The three register select inputs are used to select the various registers inside the GPIA. These three lines are used in conjunction with the Read/Write line to select a particular register that is to be written or read Table 2 shows the register select coding

INTERRUPT REQUEST (\overline{IRQ}) — The \overline{IRQ} output goes to the common interrupt bus line for the MPU. This is an opendrain output which is wire-ORed to the \overline{IRQ} bus line. The \overline{IRQ} is asserted low when an enable interrupt occurs and stays low until the MPU reads the interrupt status register Reading ROR will reset \overline{IRQ} to the high state.

TABLE 2 - REGISTER ACCESS

| RS2 | RS1 | RS0 | R/W | Register Title | Register Symbol |
|-----|-----|-----|-----|----------------------|--------------------|
| 0 | 0 | 0 | 1 | Interrupt Status | ROR |
| 0 | 0 | 0 | 0 | Interrupt Mask | ROW |
| 0 | 0 | 1 | 1 | Command Status | R1R |
| 0 | 0 | 1 | 0 | Unused | - |
| 0 | 1 | 0 | 1 | Address Status | R2R |
| 0 | 1 | 0 | 0 | Address Mode | R2W |
| 0 | 1 | 1 | 1 | Auxiliary Command | R3R |
| 0 | 1 | 1 | 0 | Auxiliary Command | R3W |
| 1 | 0 | 0 | 1 | Address Switch* | R4R |
| 1 | 0 | 0 | 0 | Address | R4W |
| 1 | 0 | 1 | 1 | Serial Poll | R5R |
| 1 | 0 | 1 | 0 | Serial Poll | R5W |
| 1 | 1 | 0 | 1 | Command Pass-Through | R6R |
| 1 | 1 | 0 | 0 | Parallel Poll | R6W |
| 1 | 1 | 1 | 1 | Data In | R7R |
| 1 | 1 | 1 | 0 | Data Out | R7W |

^{*}External to MC68488

RESET – The RESET input provides a means of resetting the GPIA from a hardware source. In the low state, the RESET input causes the following:

- The Interrupt "Mask" register is reset.
- All status conditions are reset;
- The GPIA is placed in the Untalk/Unlisten state,
- The Parallel Poll, Serial Poll, Data In, and Data Out registers are reset,
- The Address register and Address mode register are cleared.
- All stored conditions in the Auxiliary Comand register except bit 7 are reset — (bit 7 is set),
- T/R1, 2 will go to the low state.

When RESET returns high (the inactive state) the GPIA will remain in the reset condition until the MPU writes bit 7 of the Auxiliary Command register (R3W) low Prior to the release of the software reset bit, the only register that can be accessed is the Address register. The conditions affected by the RESET pin cannot be changed while this pin is low.

E (ENABLE CLOCK) — E activates the address inputs (CS, RS0, RS1, and RS2) and R/W input and enables data transfer on the MPU data bus. It is also used internally as a state counter allowing the device to change interface states. The E input should be connected to a free-running clock source such as the MC6800 ϕ 2 or the Enable Signal of other M6800 family MPUs.

GPIA/GPIB INTERFACE BUS SIGNALS

The GPIA provides a set of eighteen interface signal lines between the M6800 and the IEEE-488 Standard bus.

NOTE

The IEEE-488 Standard defines these signals as negative logic. In this document all MPU and MC68488 signals are defined as positive logic.

SIGNAL LINES (IBO-IB7) — These bidirectional lines allow for the flow of 7-bit ASCII interface messages and device dependent messages. Data appears on these lines in a bit-parallel byte-serial form. These lines are buffered by transceivers and applied to the IEEE-488 Standard bus (DIO1-DIO8).

BYTE TRANSFER LINES (DAC, RFD, $\overline{\text{DAV}}$) — These lines allow for proper transfer of each data byte on the bus between sources and acceptors RFD goes passively high indicating "Ready For Data" A source will indicate the "data is valid" by pulling $\overline{\text{DAV}}$ low Upon the reception of valid data, DAC will go passively high indicating that the "data has been accepted" by all acceptors. The handshake lines have internal pullup resistors.

BUS MANAGEMENT LINES (ATN, IFC, SRQ, EOI, REN) — These lines are used to manage an orderly flow of information across the interface lines

ATTENTION ($\overline{\text{ATN}}$) — is continuously monitored by the GPIA. The device responds to any changes on this line in less than 200 ns by activating the transmit/receive control signals. If the $\overline{\text{EOI}}$ line and $\overline{\text{ATN}}$ are low at the same time, GPIA will place the contents of a parallel poll register on the IEEE-488 Standard bus.

INTERFACE CLEAR (IFC) - is used by a system controller to put the GPIA in a known guiescent state. The occurrence of IFC will place the GPIA in the Listener/Talker idle state (LIDS or TIDS). If the MC68488 is in a Listener Active state with a byte of data in the Data-In register (BI bit set) an IFC will place the part in LIDS but will not destroy the received byte nor the status indication (BI). Any interface function that requires the device to be in either the Listener or Talker Active state (e.g., a Serial Poll enable command) will be reset if an IFC occurs. A command that originates from the MPU (e.g., to, lo, fget, hlda) will only be affected during the occurrence of an IFC (when IFC is low) and will return to its programmed state when IFC returns high, i.e., IFC will not affect local messages. For example: if the GPIA is in TACS (Talker Active State) and has placed a byte in the Data-Out register it has made a new byte available (nba) If IFC occurs while the source handshake is in SDYS, the talker function will be returned to its idle state but nba (a local message) will not be destroyed. When the GPIA is again made a talker, the byte in the Data-Out register (placed there before IFC) will be placed onto the GPIB. The address register is not affected by an IFC

SERVICE REQUEST (SRQ) — is used to indicate a need for attention in addition to requesting an interruption in the current sequence of events. This indicates to the controller that a device on the bus is in need of service. This output becomes active low by setting the rsv bit (bit 6) of R5W. This line is an open drain and an external pullup resistor (nominal 3 3k ohm) must be used.

REMOTE ENABLE (REN) — is used to select one of two alternate sources of device programming data — local and remote control. When this input is low the GPIA is enabled to move to the REMS state. Note that REN being low is a necessary but not a sufficient condition for moving to REMS.

END OF IDENTIFY (EOI) — Serves a dual purpose. When the GPIA is in TACS and the MPU writes bit 5 or R3W (feoi) this pin becomes an output and signals the end of a multibyte transfer. If the system controller makes the EOI line true in conjunction with ATN, the contents of the Parallel Poll register will be placed on the IEEE-488 Standard bus

TRANSMIT/RECEIVE CONTROL SIGNALS (T/ $\bar{R}1$, T/ $\bar{R}2$) — These two signals are used to control the quad or octal transceivers which drive the interface bus It is assumed that transceivers equivalent to the MC3447 or MC3448A will be used where each transceiver has a separate Transmit/Receive control pin. These pins can support one TTL load each. The outputs can then be grouped and the control for SRQ hardwired high to transmit The Transmit/Receive inputs of $\bar{R}EN$, $|\bar{F}C$, and $\bar{A}T\bar{N}$ are hardwired low to receive $E\bar{O}$ is controlled by T/ $\bar{R}1$ through the MC3447/MC3448A (or equivalents) allowing it to transmit or receive. $T/\bar{R}1$ operates exactly as $T/\bar{R}2$ except during the parallel polling sequence During parallel poll, $E\bar{O}$ will be made an input by $T/\bar{R}1$ while $\bar{D}AV$ and BO/B7 lines are outputs

SPECIAL CONTROL SIGNALS

DMA CONTROL LINES (DMA GRANT, DMA REQUEST — The DMA request line is used to signal a DMA controller that a data transfer is pending. The DMA request line is set high if either the BI or BO status bits are set in the Interrupt Status Register (R0R). The DMA request line is cleared when the DMA Grant is true. The DMA Grant line is used to signal the GPIA that the DMA has control of the MPU data and address lines. The DMA Grant, when set high, selects register 7. It also inhibits the R50, RS1, and RS2 lines During this time the $\overline{\text{CS}}$ input must be high. The DMA Grant also inverts the function of the R/\overline{W} line making it \overline{R}/W . Thus, if the DMAC supplies a write function to a memory location, this same line will perform a read of the GPIA (R7R) and vice versa

NOTE

DMA GRANT MUST BE GROUNDED WHEN NOT IN USE

TRIGGER OUTPUT (TRIG) — The TRIG pin provides an output corresponding to the GET and fget commands. A hardware or software reset places this output at a low level. The trigger output can be programmed high by either of two methods.

- 1 Setting fget (bit 0 of R3W) by the MPU causes the trigger output to be set. It remains set until the fget bit is programmed low or until a reset occurs.
- The Trigger Output is set upon reception of a GET command from the controller It is reset when the GPIA moves out of DTAS (Device Trigger Active State), i.e., when GET, LADS, or ACDS occur

ADDRESS SWITCH ENABLE (\overline{ASE}) — The \overline{ASE} output is used to enable three-state buffers that connect instrument address switches to the MPU data bus. This output pin is pulsed low when the Address Switch Register of the GPIA is read (R4R), i.e., a read of R4R will drive the \overline{ASE} line low for the E clock that is used to read R4R.

GPIB HANDSHAKE SEQUENCE

The GPIB handshake line transitions are debounced inside the GPIA with the E-clock to provide a high degree of noise immunity. Due to the asynchronous nature between the GPIB handshake line transitions and the internal debounce circuit sampling, the time required for handshake completion can vary by 1 E clock cycle.

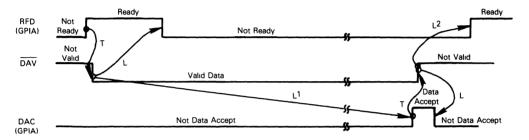
LISTENER MODE — The handshake sequence begins when the GPIA makes RFD true (Figure 8). A second byte cannot be transferred on the GPIB until the GPIA again makes RFD true for the next handshake. The total time required by the GPIA to debounce all of the handshake lines in the appropriate time sequence is 7-8 E clock cycles. The 1 cycle variation is due to the asynchronous nature of the GPIB with respect to the GPIA debounce circuitry. To determine the maximum throughput rate add this number to the number of instructions or DMA cycles used to service each transfer.

MC68488 • MC68A488 • MC68B488

TALKER MODE — The handshake sequence begins when the listener(s) on the GPIB make the RFD line true (Figure 9). When this occurs and the MPU has written a byte to R7W the 'GPIA' will make the $\overline{\text{DAV}}$ line low indicating to the listeners that valid data is on the GPIB. When this byte is accepted and RFD is again made true the next transfer can begin. The GPIA debounce circuitry requires 6-7 E clock

cycles to complete a handshake sequence. As with the listener there is a 1 E clock fluctuation due to the asynchronous nature between the GPIB handshake and the GPIA debounce circuitry. To determine the maximum throughput rate add this number to the number of instructions or DMA cycles used to service each transfer.

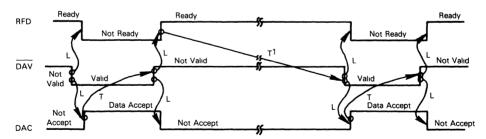
FIGURE 8 - GPIA IN LISTEN MODE*



The GPIA in the listener mode controls the DAC and RFD lines. The DAV line is controlled by the Talker on the GPIB. Note that the RFD and DAC lines are wire ANDed on the GPIB; thus, these lines returning to the high state are dependent on all devices programmed as listeners releasing the lines.

- L The listener(s) on the GPIB causes this action
- T The talker on the GPIB causes this action
- 1 The release of DAC may require action by the MPU (reading R7R for data byte transfers or writing dacr (R3W) high for certain commands). For some commands DAC is automatically released by the GPIA. Consult the MC68488 user's manual for details
- 2 The RFD line is normally automatically released by the GPIA Certain conditions, however, require MPU intervention to provide this release. Consult the MC68488 user's manual for details

FIGURE 9 — GPIA IN TALKER MODE*



- The GPIA in the talker mode controls the DAV line. The RFD and DAC lines are controlled by the listener(s) on the GPIB.
- L The listener(s) on the GPIB causes this action
- T The talker on the GPIB causes this action
- 1 Two conditions must occur before the DAV line goes to the valid state. The RFD line must be high and a data byte must be placed in the data out register (nba must be true)

GPIA INTERNAL CONTROLS AND REGISTERS*

There are fifteen locations accessible to the MPU data bus which are used for transferring data to control the various functions on the chip and provide current chip status. Seven of these registers are write only and eight registers are read only. The various registers are accessed according to the three least-significant bits of the MPU address bus and the status of the Read/Write line. One of the fifteen registers is external to the IC but an address switch register is provided for reading the address switches. Table 2 shows actual bit contents of each of the registers.

DATA-IN REGISTER R7R — The data-in register is an actual 8-bit storage register used to move data from the interface bus when the chip is a listener. Reading the register does not destroy information in the data-out register. DAC (data accepted) will remain low until the MPU removes the bytes from the data-in register. The chip will automatically finish the handshake by allowing DAC to go high. In RFD (ready for data) holdoff mode, a new handshake is not initiated until a command is sent allowing the chip to release holdoff. This will delay a talker until the available information has been processed.

Data-In Register (Read Only)

| (Nead Only) | | | | | | | | | | | |
|-------------|-----|-----|-----|-----|-----|-----|-----|--|--|--|--|
| D17 | D16 | D15 | D14 | D13 | D12 | D11 | D10 | | | | |

D10-D17 — Correspond to DIO1-DIO8 of the 488-1975 Standard and IBO-IB7 of the MC68488

•NOTE Upper and lower case type designations will be used with the register bits to indicate remote or local messages respectively **DATA-OUT REGISTER R7W** — The data-out register is an actual 8-bit storage register used to move data out of the chip onto the interface bus. Reading from the data-in register has no effect on the information in the data-out register. Writing to the data-out register has no effect on the information in the data-in register

| Data-Out | Register |
|----------|----------|
| (Write | Only) |
| | |

| _ | _ | - | _ | | _ | _ | |
|-----|-----|-----|-----|-----|-----|-----|-----|
| D07 | D06 | DO5 | DO4 | DO3 | DO2 | DO1 | 000 |
| -0. | | | | | | | |

DO0-DO7 — Correspond to DIO1-DIO8 of the 488-1978 Standard and $\overline{IB0}$ - $\overline{IB7}$ of the MC68488

INTERRUPT MASK REGISTER ROW - The Interrupt Mask Register is a 7-bit storage register used to select the particular events that will cause an interrupt to be sent to the MPU. The seven control bits may be set independently of each other If dsel (bit 7 of the Address Mode Register) is set high CMD bit 2 will interrupt on SPAS or RLC. If dsel is set low CMD will interrupt on UACG, UUCG, and DCAS in addition to RLC and SPAS. The Command Status Register R1Rmay then be used to determine which command caused the interrupt Setting GET bit 5 allows an interrupt to occur on Group Execute Trigger Command. END bit 1 allows an interrupt to occur if EOI is true (low) and ATN is false (high). APT bit 3 allows an interrupt to occur indicating that a secondary address is available to be examined by the MPU if apte (bit 0 of Address Mode Register) is enabled and listener or talker primary address is received and a Secondary Command Group is received. A typical response for a valid secondary address would be to set msa (bit 3 of Auxiliary Command Register) true and dacr (bit 4 Auxiliary Command Register) true, releasing the DAC handshake. Bl indicates that a data

TABLE 3 - REGISTER CONTENTS

| | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-----|-------|------|------|------|------|------|------|------|
| ROW | IRQ | BO | GET | | APT | CMD | END | BI |
| ROR | INT | во | GET | | APT | CMD | END | ВІ |
| R1R | UACG | REM | LOK | | RLC | SPAS | DCAS | UUCG |
| R1W | | | | | | | | |
| R2R | ma | to | lo | ATN | TACS | LACS | LPAS | TPAS |
| R2W | dsel | to | lo | | hlde | hlda | | apte |
| R3R | RESET | DAC | DAV | RFD | | | ulpa | |
| R3W | HESEI | rfdr | feoi | dacr | msa | rtl | dacd | fget |
| R4R | UD3 | UD2 | UD1 | AD5 | AD4 | AD3 | AD2 | AD1 |
| R4W | Isbe | dal | dat | AD5 | AD4 | AD3 | AD2 | AD1 |
| R5R | S7 | SRQS | S5 | S4 | S3 | S2 | S1 | 00 |
| R5W | 3/ | rsv | 39 | 54 | 33 | 52 | 31 | S0 |
| R6R | В7 | В6 | B5 | B4 | В3 | B2 | B1 | В0 |
| R6W | PPR8 | PPR7 | PPR6 | PPR5 | PPR4 | PPR3 | PPR2 | PPR1 |
| R7R | DI7 | ÐI6 | DI5 | DI4 | DI3 | DI2 | DI1 | DI0 |
| R7W | D07 | D06 | D05 | D04 | D03 | DO2 | D01 | D00 |

Interrupt "Mask Register"
Interrupt Status Register
Command Status Register
Unused
Address Status Register
Address Mode Register
Auxiliary Command Register
Address Switch Register
Address Register
Serial Poll Register

Command Pass-Through Register
Parallel Poll Register
Data In Register
Data Out Register

Notes

- 1 Upper case letters indicate a message resulting from the IEEE-488 Standard bus
- 2 Lower case letters indicate a message resulting from the MPU data bus
- 3 The bit terminology of the Data In and Data registers represent the numbering of the IEEE-488 Standard bus and not the 6800 MPU bus see Section 3.1.2

byte is waiting in the data-in register. BI is set high when data-in register is full. BO indicates that a byte from the data-out register has been accepted. BO is set when the data-out register is empty. IRQ enabled high allows any interrupt to be passed to the MPU.

Interrupt Mask Register (Write Only)

| | | | | , | | | |
|-----|----|-----|---|-----|-----|-----|----|
| IRQ | во | GET | Х | APT | CMD | END | ВІ |
| | | | | | | | |

IRQ - Mask bit for IRQ pin

BO - Interrupt on byte output

GET - Interrupt on Group Execute Trigger

APT - Interrupt on Secondary Address Pass-Through

CMD - Interrupt on SPAS+RLC+dsel (DCAS+

UUCG + UACG)

END - Interrupt on EOI and ATN
BI - Interrupt on byte input

THE INTERRUPT STATUS REGISTER ROR — The Interrupt Status Register is a 7-bit storage register which corresponds to the interrupt mask register with an additional bit INT bit 7 Except for the INT bit the other bits in the status register are set regardless of the state of the interrupt mask register when the corresponding event occurs. The $\overline{\text{IRO}}$ (MPU interrupt) is cleared when the MPU reads from the register. INT bit 7 is the logical OR of the other six bits ANDed with the respective bit of ROW.

Interrupt Status Register

| | | | Inda | u Only | | | |
|-----|----|-----|------|--------|-----|-----|----|
| INT | во | GET | Х | APT | CMD | END | ВІ |

INT - Logical OR of all other bits in this register ANDed with the respective bits in the interrupt mask

register

BO — A byte of data has been output

GET – A Group Execute Trigger has occurred
APT – An Address Pass-Through has occurred
CMD – SPAS+RLC+dsel (DCAS+UUCG+UACG)

has occurred

END - An EOI has occurred with ATN=0

A byte has been received

SERIAL POLL REGISTER R4R/W — The Serial Poll Register is an 8-bit storage register which can be both written into and read by the MPU. It is used for establishing the status byte that the chip sends out when it is serial poll enabled. Status may be placed in bits 0 through 5 and bit 7. Bit 6 rsv (request for service) is used to drive the logic which controls the \overline{SRO} line on the bus telling the controller that service is needed. This same logic generated the signal SRQS which is substituted in bit 6 position when the status byte is read by the MPU $\overline{IBO-IB7}$. In order to initiate a rsv (request for service), the MPU sets bit 6 true (generating rsv signal) and this in turn causes the chip to pull down the \overline{SRO} line. SRQS is the same as rsv when SPAS is false. Bit 6 as read by the MPU will be the SRQS (Service Request State)

Serial Poll Register (Read)

| | | | (R | ead) | | | |
|------|------|----|----|------|----|----|----|
| S8 | SRQS | S6 | S5 | S4 | S3 | S2 | S1 |

S1-S8 - Status bits

SRQS - Bus in Service Request State

Serial Poll Register (Write)

| S8 | rsv | S6 | S5 | S4 | S3 | S2 | S1 |
|----|-----|----|----|----|----|----|----|

S1-S8 - Status bits

y — generate a service request

PARALLEL POLL REGISTER R6W — This register will be loaded by the MPU and the bits in this register will be delivered to the instrument bus IBO-IB7 during PPAS (Parallel Poll Active State). This register powers up in the PPO (Parallel Poll No Capability) state The reset bit (Auxiliary Command Register bit 7) will clear this register to the PPO state

The parallel poll interface function is executed by this chip using the PP2 subset (Omit Controller Configuration Capability) The controller cannot directly configure the parallel poll output of this chip. This must be done by the MPU. The controller will be able to indirectly configure the parallel poll by issuing an addressed command which has been defined in the MPU software.

Parallel Poll Register (Write Only)

| _ | | | | | | | |
|-----|-----|-----|-----|-----|-----|-----|-----|
| PP8 | PP7 | PP6 | PP5 | PP4 | PP3 | PP2 | PP1 |

Bits delivered to bus during Parallel-Poll Active State (PPAS)

Register powers up in the PP0 state Parallel Poll is executed using the PP2 subset

ADDRESS MODE REGISTER R2W — The address mode register is a storage register with six bits for control to, lo, hide, hida, dsel, and apte. The to bit 6 selects the talker/listener and addresses the chip to talk only. The lo bit 5 selects the talker/listener and sets the chip to listen only. The apte bit 0 is used to enable the extended addressing mode. If apte is set low the device goes from the TPAS (Talker Primary Address State) directly to the TADS (Talker Addressed State). The hida bit 2 holds off RFD (Ready for Data) on ALL DATA until rfdr is set true. The hide bit 3 holds off RFD on EOI enabled (low) and ATN not enabled (high) This allows the last byte in a block of data to be continually read as needed. Writing rfdr true (high) will allow the next handshake to proceed.

Address Mode Register (Write Only)

| | | | (4411 | te Office | <u>'</u> | | |
|------|----|----|-------|-----------|----------|---|------|
| dsel | to | lo | Х | hdle | hdla | Х | apte |

dsel – configure for automatic completion of handshake sequence on occurrence of GET, UACG, UUCG, SDC, or DCL commands

to - set to talk-only mode

lo – set to listen-only mode

hdle - Hold-off RFD on end (END = $EOI\Lambda \overline{ATN}$)

hdla - Hold-off RFD on all data

apte - Enable the address pass-through feature

ADDRESS STATUS REGISTER R2R — The address status register is not a storage register but simply an 8-bit port used to couple internal signal modes to the MPU bus. The status flags represented here are stored internally in the logic of the chip. These status bits indicate the addressed state of the talker/listener as well as flags that specify whether the chip is in the talk only or listen only mode. The ATN, bit 4, contains the condition of the Attention Line. The ma signal is true when the chip is in.

TACS — Talker Active State
TADS — Talker Addressed State
LACS — Listener Active State
LADS — Listener Addressed State
SPAS — Serial Poll Active State

ma - my address has occurred

ma

to - the talk-only mode is enabled
- the listen-only mode is enabled

ATN — the Attention command is asserted TACS — GPIA is in the Talker Active State

LACS - GPIA is in the Listener Active State
LPAS - GPIA is in the Listener Primary Addressed State

TPAS — GPIA is in the Listerier Primary Addressed State

ADDRESS SWITCH REGISTER R4R — The address switch register is external to the chip. There is an enable line (\overline{ASE}) to be used to enable three-state drivers connected between the address switches and the MPU. When the MPU addresses the address switch register the \overline{ASE} line directs the switch information to be sent to the MPU. The five least-significant bits of the 8-bit register are used to specify the bus address of the device and the remaining three bits may be used at the discretion of the user. The most probable use of one or two of the bits is for controlling the listener only or talk only functions.

Address Switch Register (Read Only)

| UD3 UD2 UD1 AD5 AD4 AD3 AD2 AD1 | | | | | | | | |
|---------------------------------|-----|-----|-----|-----|-----|-----|-----|-----|
| | UD3 | UD2 | UD1 | AD5 | AD4 | AD3 | AD2 | AD1 |

AD1-AD5 - Device address

UD1-UD3 - User definable bits

When this "register" is addressed, the ASE pin is set which allows external address switch information from the bus device to be read

ADDRESS REGISTER R4W — The Address Register is an 8-bit storage register. The purpose of this register is to carry the primary address of the device. The primary address is placed in the five least-significant bits of the register. If external switches are used for device addressing these are normally read from the Address Switch Register and then placed in the Address Register by the MPU.

AD1 through AD5 bits 0-5 are for the device's address. The lsbe bit 7 is set to enable the Dual Primary Addressing Mode. During this mode the device will respond to two consecutive addresses, one address with AD1 equal to 0 and the other address with AD1 equal to 1. For example, if the device's address is HEX 0F, the Dual Primary Addressing Mode would allow the device to be addressed at both

HEX.0F and HEX 0E. The dal bit 6 is set to disable the listener and the dat bit 5 is set to disable the talker

This register is cleared by the RESET input only (not by the reset bit of the Auxiliary Command Register bit 7)

When ATN is enabled and the primary address is received on the IBO-7 lines, the MC68488 will set bit 7 of the address status register (ma). This places the MC68488 in the TPAS or IPAS

When $\overline{\text{ATN}}$ is disabled the GPIA may go to one of three states. TACS, LACS, or SPAS

Address Register (Write Only)

| | | | (******* | o omy, | | | |
|------|-----|-----|----------|--------|-----|-----|-----|
| Isbe | dal | dat | AD5 | AD4 | AD3 | AD2 | AD1 |

Isbe - enable dual primary addressing mode

dal – disable the listener dat – disable the talker

AD1-AD5 — Primary device address, usually read from address switch register

witch register

Register is cleared by the RESET input pin only

AUXILIARY COMMAND REGISTER R3R/W

 Bit 7, reset, initializes the chip to the following states: (reset is set true by external RESET input pin and by writing into the register from the MPU)

SIDS - Source Idle State

AIDS - Acceptor Idle State

TIDS - Talker Idle State

LIDS - Listener Idle State

LOCS - Local State

NPRS - Negative Poll Response State

PPIS - Parallel Poll Idle State

PUCS - Parallel Poll Unaddressed to Configure State

PPO - Parallel Poll No capability

rfdr (release RFD handshake) bit 6 allows for completion of the handshake that was stopped by RFD (Ready For Data) holdoff commands hida and hide

fget (force group execute trigger) bit 0 has the same effect as the GET (Group Execute Trigger) command from the controller

rtl (return to local) bit 2 allows the device to respond to local controls and the associated device functions are operative

dacr (release DAC handshake) bit 4 is set high to allow DAC to go passively true. This bit is set to indicate that the MPU has examined a secondary address or an undefined command

upla (upper/lower primary address) bit 1 will indicate the state of the LSB of the address received on the DIO1-8 bus lines at the time the last Primary Address was received. This bit can be read but not written by the MPU

msa (valid secondary address) bit 3 is set true (high) when TPAS (Talker Primary Addressed State) or LPAS (Listener Primary Addressed State) is true. The chip will become addressed to listen or talk. The primary address must have been previously received.

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RFD, DAV, DAC - (Ready For Data, Data Valid, Data Accepted) bits assume the same state as the corresponding signal on the MC68488 package pins. The MPU may only read this bit. These signals are not synchronized with the MPLL clock

dacd (data accept disable) bit 1 set high by the MPU will prevent completion of the automatic handshake on Addresses or Commands, dacr is used to complete the handshake

feoi (forced end or identify) bit 5 tells the chip to send EOI low. The EOI line is then returned high after the next byte is transmitted. NOTE: The following signals are not stored but revert to a false (low) level one clock cycle (MPUφ2) after they are set true (high).

1 rfdr

2 feoi

3 dacr

These signals can be written but not read by the MPU

Auxiliary Command Register

| ronat | rfdr | feoi | dacr | | rtl | dacd | f | Write |
|-------|------|------|------|-----|-----|------|------|-------|
| reset | DAC | DAV | RFE | msa | 110 | ulpa | iget | Read |

reset - initialize the chip to the following status

(1) all interrupts cleared

(2) following bus states are in effect SIDS, AIDS, TIDS, LIDS, LOCS, PPIS, PUCS, and PPO (3) bit is set by RESET input pin

if GPIA is in LPAS or TDAS, setting msa will force GPIA to LADS or TADS

return to local if local lookout is disabled

ulpa state of LSB of bus at last-primary-address receive time

fget force group execute trigger command from the MPU has occurred

rfdr continue handshake stopped by RFD holdoff

set EOI true, clears after next byte transmitted feoi -

dacr -MPU has examined an undefined command or secondary address

dacd - prevents completion of automatic handshake on Addresses or Commands

COMMAND STATUS REGISTER R1R - The command status register flags command or state as they occur. These flags or states are simply coupled on the MPU bus. There are five major address commands REM shows the remote/local state of the talker/listener REM bit 6, set low, implies the local state LOK bit 5 shows the local lockout status of the talker/listener. RLC bit 3 is set when a change of state of the remote/local flip-flop occurs and reset when the command status register is read. DCAS bit 1 indicates that either the device clear or selected device clear has been received activating the device clear function SPAS bit 2 indicates that the SPE command has been received activating the device serial poll function. UACG bit 7 indicates that an undefined address command has been received and depending on programming the MPU decides whether to execute or ignore it UUCG bit 0 indicates that an undefined universal command has been received

Command Status Register

| UACG | REM | LOK | Х | RLC | SPAS | DCAS | UUCG |
|------|-----|-----|---|-----|------|------|------|

UACG - Undefined Addressed Command

RFM -Remote Enabled

LOK Local Lockout Enabled RLC

Remote/Local State Changed SPAS - Serial Poll Active State is in effect

DCAS - Device Clear Active State is in effect UUCG - Undefined Universal Command

COMMAND PASS-THROUGH REGISTER R6R - The command pass through is an 8-bit port with no storage When this port is addressed by MPU it connects the instrument data bus (IBO-IB7) to the MPU data bus D0-D7 This port can be used to pass commands and secondary addresses that aren't automatically interpreted through to the MPU for inspection

Command Pass-Through Register

| | | | (Read | d Only) | | | |
|----|----|----|-------|---------|----|----|----|
| В7 | В6 | B5 | · B4 | В3 | B2 | B1 | В0 |

An 8-bit input port used to pass commands and secondary addresses to MPU which are not automatically interpreted by the GPIA

PROGRAMMING CONSIDERATIONS

The following is a list of considerations when using the MH version of the MC68488.

Handshake Interruption

Once a handshake sequence begins on the IEEE-488 bus it should be allowed to complete in a normal fashion, as described in the IEEE Standard. If this sequence is interrupted (e.g., the controller forces the DAV line to the not data valid state prematurely) the integrity of the data is lost and the interface devices can go to unintended states, as explained in the standard NOTE The MC68488 does not interrupt a handshake It always allows the handshake to complete in the correct sequence, however, it is possible for a device, other than a MC68488, connected to the bus to interrupt the sequence. The controller can do this through an asynchronous Bus Take-over (asserting the ATN line during a handshake) If this occurs the controller should follow the asynchronous take-over with an IFC Uniline Command (ATN can be either asserted or not asserted at this time) It is also possible for some devices to interrupt the handshake by prematurely making the DAV line false (this type of interrupt should be avoided and it should be noted that the MC68488 does not interrupt the handshake sequence) If the DAV handshake line is made false (high) before DAC is made false (high) during a handshake sequence, the listener GPIA(s) will respond as follows

a) If IFC is sent by the controller with ATN false before another handshake sequence is initiated the MC68488 will reset back to an idle state. The GPIA at this point is ready to be reprogrammed

The BI status bit may be set, depending on when the handshake was interrupted, but any byte in R7R cannot be considered valid NOTE: If IFC is sent with ATN true, it must be sent again with ATN false.

b) If another handshake is initiated before IFC is sent with ATN false, the GPIA does not generate interrupts for subsequent data bytes received by the listener GPIA(s). The device responds to commands and moves into and out of TACS, LACS, etc., but no further BI interrupts are generated. The only solutions to this situation are to reset the MC68488 or have the MPU perform a read of R7R register in the

2. Interrupt Structure

The status bits in ROR, when set, cause an interrupt (drives the IRQ line low) if the appropriate interrupt mask bits in ROW are set. The IRQ line is sensitive to a low-to-high transition produced by the logical OR of the appropriate bits in ROR If, for example the BI status bit is set and causes an IRQ interrupt, the MPU reads ROR (this read will reset the IRQ line but not the status bit) and detect that the BI bit is set. The software should then direct the MPU to read the data byte from R7R, which in turn causes the BI bit to be reset If after the status register (ROR) was read and before R7R is read, another interrupt status bit is set (e.g., the CMD bit) this second condition does not cause an interrupt. The BI bit being set at the time CMD occurred prevents the IRQ line from detecting the necessary low-to-high transition and an interrupt could be missed. To prevent this, the last set of instructions in the software interrupt handler should be a reset of the interrupt mask register, followed by programming this same register to its original state. This always produces the needed low-to-high transition, preventing missed interrupts.

3 The "nba" for TACS affects "nba" for SPAS

If nba for TACS is false (there is not a data byte pending in R7W) then the serial poll handshake sequence for the status byte to the controller occurs once. If nba for TACS is true (there is a data byte in R7R waiting for a handshake to listeners) then the status byte will be sent to the controller each time the controller completes a handshake and indicates that it is ready for more data.

4 The "nba" for SPAS affects "nba" for TACS

The controller places the GPIA into the Serial Poll Active State (SPAS) by sending serial Poll enable, sending the device talk address, and then releasing ATN If the controller does this and never accepts the serial Poll Status byte (never makes the RFD handshake line true) but rather the controller asserts ATN and sends Serial Poll Disable (SPD), then the GPIA moves into and out of SPAS without completing the status byte handshake routine. In this state the "nba" for SPAS remains true and affects "nba" for TACS in the following way:

When the controller places the GPIA in TACS

the part makes DAV true as soon as RFD is made true by the listeners in a normal sequence. However, the GPIA continues the handshake sequence, using the contents of R7W, over and over, (i.e., Each time the listeners accept the current data byte and makes RFD true, the GPIA makes DAV true automatically and begins another handshake sequence.) The B0 status bit is set, however, and if the MPU writes to R7W the new data byte is sent to the listeners over and over, using a handshake routine. This continual sending of data bytes occurs until the controller places the GPIA back in SPAS and completes the handshake routine for the Serial Poll Status byte making "nba" for SPAS false again.

This situation does not occur if the controller handshakes the status byte when it places the GPIA in SPAS.

5 Dual Addressing

Dual addressing implies the use of two adjacent primary addresses and, as such, care should be taken when selecting the primary addresses for this mode Decimal address 30 (11110) should not be used because the dual address counterpart of decimal 30 is decimal 31 (11111). Since address 31 has the same bit code as that of either the Untalk or Unlisten Commands this value is an invalid primary address for the IEEE-488 system.

6 "Ghost Interrupts"

A "ghost interrupt" is an interrupt that occurs as a result of the MC68488, but when the status register is checked no status bits are set. There are two conditions that can legitimately cause a "ghost interrupt" They are:

a) SPAS status bit

If the controller conducts a serial poll by sending Serial Poll Enable (SPE) and then sends the GPIA talk address, the SPAS status bit is set and can cause an interrupt. After the controller receives the Serial Poll Status byte it will send Serial Poll Disable (SPD) which resets the SPAS status bit. If the controller can perform this sequence of events before the interrupt handler can check the SPAS status bit, the MPU will not find any status bits set ("ghost interrupt"). The possibilities are twofold:

- If this device had actually requested the service, then the MPU, after receiving the interrupt ("ghost" or not), should check bit 6 of the Serial Poll register. If this bit is reset the MPU knows that a Serial Poll was conducted and can reset the rsv as per normal Serial Poll handling procedures.
- If this device did not request the service request and SPAS is not set, the software should detect this as a "ghost interrupt," ignore it, and proceed with normal operations.

See "Serial Poll Procedure" (#11) for further Serial Poll operation.

b) B0 status bit

The B0 Status bit is set whenever the MC68488 is in the Talker Active State and the output register (R7W) is empty. After the listener(s) accept the current data byte on the IEEE bus, the B0 status bit will again be set and with the appropriate mask bits set, will cause an interrupt. When the talker sends the last byte of a string it is possible for the controller to detect this, synchronously take control of the bus, and untalk the talker; however, when the last byte is accepted the B0 status bit is again set and if so programmed, causes another interrupt. It is possible for the controller to untalk the device thereby resetting B0 before the MPU interrupt handler is able to check the status register Under these conditions a "ghost interrupt" occurs. See "Send Last Byte Procedure" (#10) for further description and solution

7 UACG Status Bit

The UACG status bit is set anytime the GPIA receives an Undefined Address Command Group (UACG) message from the controller. This bit is not qualified with the addressed state of the part. The MPU software, after detecting a UACG, must check the ma bit in the address status register to see if the device is addressed. If the UACG message is a selected command only pertinent to addressed listeners, the software, after receiving the command by reading R6R, should release the handshake (write dacr high in R3W). This allows the controller to make ATN false. If the device has been addressed to listen/talk and ATN is made false the LACS/TACS status bit in the address status register will be set. The MPU can then check these bits

8. END Status Bit

The END status bit in R0R is used to indicate to addressed listeners that the next byte received by the addressed talker is the last byte of a string. This bit is not qualified with the handshake and thus occurs ahead of the reception of the last data byte. This alerts the MPU that the final byte will soon follow. Because of this, two interrupts, if so programmed, will occur. One for the END bit and one for the BI bit when the final byte is transferred with a handshake. For those situations where it is inconvenient to have two interrupts the END status bit can be masked, not allowing it to cause an interrupt

9 feoi (force end or identify)

This control bit (bit 5, R3W) is used when the MC68488 is an Active Talker, to indicate to the listener(s) on the IEEE bus the end of a data string transfer. The MC68488 asserts the EOI management line when the feoi control bit is set and the device is in the Talker Active State (TACS). The feoi bit is set by the MPU writing this bit high and automatically resets one E clock cycle after it was set. The use of this function is as follows: When sending a string of data the feoi control bit should be set prior to sending the final data byte. This causes the EOI management line to be asserted (low). The final data byte can now be sent The EOI line remains asserted until this byte is accepted, at which time it returns high.

Care must be used when setting the feoi control bit Once feoi has been written high, the EOI line is asserted when the MC68488 is an Active Talker and remains asserted until the next data byte is sent and accepted. This is true even if feoi is written high while the device is not an Active Talker. In this case the EOI management line is asserted as soon as the MC68488 is again made an Active Talker. Once the feoi control bit is set, only a device reset prevents the END message from being sent when the MC68488 becomes an Active Talker.

10. Send Last Byte Procedure (Talker Mode)

The procedure used for sending the last byte is described below When using the EOI management line, the MPU software must first set the feoi control bit (asserting EOI), and then send the last byte. When the last byte is accepted by all listeners, the B0 status bit of the talker device is set. The B0 status bit is not qualified with the EOI line, but is set whenever the current data byte is accepted by all listeners and the device is in the Talker Active State (TACS) (Note that when the controller asserts ATN to send commands. the GPIA moves out of TACS causing B0 to reset and remains out of TACS as long as ATN is asserted.) After the data block transfer, the controller takes control of the bus (asserts ATN) and reconfigures the GPIB system In performing this task, the controller sends command(s) that untalk the device (MLA, OTA, UNT) or reassigns it as a Talker (MTA) asking for further data transfers. Since the GPIB operates asynchronously with respect to the device MPU bus, it is possible for the controller to take control of the GPIB and cause actions that change the state of the BO status bit in the middle of the MPU interrupt routine. As a result, care needs to be exercised when responding to the B0 status bit interrupt occurring after transferring the last byte. Any of the following conditions can occur

- Device Untalked If either My Listen Address, Other Talk Address, or the Untalk command is sent, the device is placed in the Talker Idle State (TIDS) the device is Untalked. In this case the B0 status bit is set as soon as the last data byte is accepted, reset when the controller asserts ATN, and B0 will remain reset after ATN is released.
 - (a) The B0 status bit indicates a set condition if the MPU reads the Interrupt Status Register before the controller asserts ATN. This status indication, however, is misleading as another byte transfer is not intended. The device is soon to be Untalked.
 - (b) The B0 status bit indicates a reset condition if the MPU reads the Interrupt Status Register after ATN has been asserted a "ghost interrupt" is produced. This B0 status bit remains reset after ATN is made false (high)
- Device Reassigned as a Talker The controller reassigns the device to talk by sending My Talk Address. In this case the BO status bit is set as

soon as the last data byte is accepted, reset when the controller asserts \overline{ATN} to send MTA, and is again set when \overline{ATN} is made false by the controller.

- (a) The B0 status bit indicates a set condition if the MPU reads the Interrupt Status Register before the controller asserts ATN. This case is identical to part (a) for "Device Untalked" shown above
- (b) The B0 status bit indicates a set condition if the MPU reads the Interrupt Status Register while ATN is asserted a "ghost interrupt" is produced
- (c) The B0 status bit indicates a set condition if the MPU reads the Interrupt Status Register after ATN is made false (high). This status indication is requesting a byte transfer and should be acted upon accordingly.

To alleviate the above ambiguity and "ghost interrupt" situation, the GPIB handshake must be synchronized with action by the device MPU. The following step-by-step procedure provides this needed synchronization and eliminates the ambiguity when servicing the BO status bit after sending the last byte

- Before sending the last byte of a block transfer, the feoi bit (if used) should be set. In addition, the dacd bit in R3W should be set, holding off the handshake upon reception of any command (establishes the required synchronization between MPU and controller).
- If operating under interrupts, the B0 interrupt mask should be reset. This prevents generation of a B0 status interrupt when the last byte is received.
- 3) Send the last data byte
- 4) The MPU now monitors the ATN bit in the Address Status Register (R2R) When the ATN bit is set, the ATN line has been asserted and it will remain asserted until completion of the handshake. The procedure, described herein, assumes that ATN line is asserted between block transfers and at least one command sent. The fact that ATN is asserted indicates that the device is no longer in TACS and, thus, the BO status bit is reset.
- 5) The dacd bit in R3W can now be written low, removing the manual handshake hold-off on subsequent commands With the same write instruction, the dacr bit should be set, releasing the handshake on the current command (write a hex 10 to R3W)
- 6) The B0 interrupt mask bit can now be set, enabling interrupts for another block transfer

After following this procedure, a B0 status condition will occur only if a second block of data is requested by the controller. In addition, the possibility of a B0 "ghost interrupt" is eliminated.

11. Serial Poll Procedure

The MPU initiates a service request by writing rsv (bit 6, R5W) high in the GPIA. At the same time, the

appropriate code should be placed in the other 7 bits. Bit 6 being set causes the \$RQ management line to go low. The GPIA enters the Serial Poll Active State (SPAS) when it receives SPE and is an active talker When it enters SPAS, the following occurs: the SPAS status bit (bit 2, R1R) is set, the CMD status bit (bit 2, R0R) is set, the \$RQ line is asserted passively false (high), the \$RQ status bit (bit 6, R5R) is reset, and the contents of R5R is placed on the GPIB data bus.

When the GPIA enters SPAS, the SPAS status bit (R1R) is set. This, in turn, causes the CMD status bit in ROR to be set. In an interrupt driven system with the CMD and IRQ mask bits set, this causes an MPU interrupt. These status bits are not latched conditions and only monitor the current state of the GPIA. If the controller places the GPIA in SPAS (sends SPE and MTA), receives the Serial Poll status byte and removes the GPIA from SPAS (sends SPD) before the MPU reads the Interrupt Status register, the contents of this register shows hex 10. Since the MPU knows that this device issued the service request, it should check bit 6 of R5W if an MPU interrupt is generated but no status bit is set If bit 6, R5R, is reset, the MPU will know the controller has performed a Serial Poll on it. However, the SRQ status bit being reset does not indicate that the status byte was accepted by the controller - that is, the handshake was completed. Rather, it indicates that the GPIA has been placed in SPAS and that the status byte has been placed on the GPIB In systems with slow responding controllers, the SRQ bit in R5R can be reset while the SPAS status bit is still set. In this case to determine when the status byte was accepted, the MPU can monitor SPAS status bit This bit is reset when the controller has removed the GPIA from the SPAS Once in SPAS, the controller must accept the Serial Poll byte before removing the device from SPAS. The rsv bit cannot be written low until the status byte has been accepted, but should be written low as soon as the status byte has been accepted by the controller

If this device has issued a service request to the controller, the following provides a procedure for handling a SPAS interrupt. The procedure only discusses Serial Poll (SPAS) interrupts. Interrupts resulting from other sources need to be incorporated as appropriate for the system application. In an interrupt driven system, the MPU normally reads the Interrupt Status Register to find the cause of the interrupt. The Interrupt Status Register must be read to release the $\overline{\text{IRO}}$ line and, in most cases, it will be read to check if something other than SPAS caused the interrupt. However, since it is possible that the SPAS status can be set and then reset before the MPU reads the register, the following procedure should also be used (even though the SPAS status is reset)

- The MPU should monitor the SRQ bit in the Serial Poll Register. This can occur as a result of either an interrupt or a polling routine.
- 2) When the SRO bit returns to zero, it indicates that the MC68488 has been placed in the Serial Poll Active State (SPAS). This does not mean that the device is in SPAS, because the con-

troller could have placed the MC68488 in SPAS and then removed the device from SPAS before the MPU reads the Serial Poll Register (R5R)

- 3) After the SRQ bit in R5R returns to zero, the MPU should read the Command Status Register and Monitor the SPAS status bit. When this bit returns to 0, it indicates that the Serial Poll Status byte has been accepted by the controller and that the MC68488 has been removed from the Serial Poll Active State (SPAS).
- 4) After the SPAS status bit returns to 0, the rsv bit (in R5W) should be written low

The GPIA uses the source handshake to send the Serial Poll status byte to the controller The GPIA does this by placing the status byte on the GPIB, and when the controller makes RFD true, the GPIA makes DAV true (low), and the handshake takes place according to the IEEE-488 Standard handshake protocol If nba for the GPIA TACS function is false at this time, the GPIA will send this byte only once, i.e., the GPIA does not make DAV true (low) a second time. If nba for the GPIA TACS function is true at this time, the GPIA sends this byte over and over, provided the controller continually makes RFD true at the end of the handshake without reconfiguring the device, i.e , the GPIA in this situation makes DAV true (low) each time it receives an RFD true from the controller. The only time nba can be true for TACS is if the device was an active talker prior to the Serial Poll sequence, and the GPIA MPU had loaded a byte in R7W Now, if the controller synchronously takes over the bus before this byte is placed on the GPIB, the nba for TACS will be true

NOTE

After a Serial Poll has been conducted on the GPIA and the SRQ bit (bit 6, R5W=0) is reset, the MPU must write the rsv (bit 6, R5W) low before another service request can be initiated

APPENDIX

GPIA MASK SET DIFFERENCES

There have been two mask sets produced for the GPIA (MC68488). They are.

G6G MASK SET — sampled in the fall of '77 (first mask set). This mask set was produced through December of 1978 and can be identified by the letters "GG" preceding the date code on top of the package

M2H MASK SET — parts available January '79 (final mask set) Any parts ordered after this date will be M2H parts. The M2H mask set replaces the G6G mask set and can be identified by the letters MH or M2H preceding the date code on top of the package. The mask set designation for later production runs is P9W. The P9W mask set is identical to the M2H in all aspects.

There are seven areas of differences between the G6G and M2H/P9W mask sets. They are.

1. RLC Status bit

This bit is used to implement the Remote/Local in-

terface function In the GG mask set the Remote/Local option should not be used, because the RLC status bit in R1R will lock up in the zero state In the MH mask version the RLC bit is completely functional and will report any change in the REM status bit

2 Extended Addressing

The GG mask version of the GPIA will not discontinue secondary addressing when the primary address of another GPIA is sent by the controller, i.e., after entering LPAS, the primary address of another device will not transfer the GPIA to LPIS. This transition from LPAS to LPIS was not fully implemented in the GG mask set. The MH mask set has fully implemented this programmed for extended addressing and receives its primary address, it will move to LPAS. If at this point the primary address of another controller is sent, the GPIA will go to its idle state (LIDS/TIDS) as per IEEE-488 1978 standard requirements

3. TPAS and LPAS Status Bits

In the GG mask set the LPAS status bit will report either LPAS or LADS. Likewise, the TPAS status bit will report either TPAS or TADS. In the MH mask set these bits only report LPAS and TPAS respectively

4. DAC Release

When the GPIA (GG mask set) in the listener mode receives a byte of data from the IEEE bus the DAC handshake will be held off until the MPU reads this data byte. The E-pulse that reads this data from R7R also releases DAC, indicating to the talker that the byte has been accepted. In the GG mask set the DAC handshake line is released on the low-to-high transition (leading edge) of the E-pulse, but the data is actually read (accepted by the MPU) on the high-to-low transition (trailing edge) If there is a very fast talker or long E-pulse width, it is possible for the talker to receive a data accept (DAC) and place the next data byte in the Data-In Register before the current one has been read out by the MPU. This will overwrite the data on the MPU bus and result in missed data. For this to occur the talker must be able to detect the DAC line going high and place the next data byte on the bus (making DAV true) before the E-pulse goes low. For a 1 MHz E-pulse this is approximately 400 ns. The MH or M2H mask set corrects this by releasing DAC after the trailing edge of the E-pulse

5 dsel (deselect)

One of the functions of the dsel bit (bit 7 of R2W) is to deselect the Group Execute Trigger (GET) command from setting the GET status bit and causing an interrupt. The GG mask version of the GPIA, when dsel is set, prevents the GET status bit from being set, but it is still possible to get an IRQ (IRQ output goes low), if enabled, when the GET command is detected. Thus, dsel inhibits the GET status condition, but not the associated interrupt. The result is a "ghost interrupt" whenever the controller sends the GET command. The MH mask set, when in dsel mode, inhibits both, GET status and its associated interrupt and eliminates this "ghost interrupt."

6. hold-on-all-data (hlda)

When in the listener mode, the GPIA provides a means of holding off the handshake on reception of data until the MPU releases the handshake. This mode occurs if the hlda (hold-on-all-data) bit in R2W is set. The MPU releases the handshake by writing rfdr (ready-for-data-release) in R3W high. In the GG mask version, if while receiving data in the listener mode the controller takes over synchronously and makes the GPIA a talker and then changes the GPIA at a later time, back to a listener, the RFD handshake will be held off on the listener command rather than waiting for the first data byte. The MH mask only holds off the handshake on data and does not hold off the handshake on any command.

7. new-byte-available (nba) During a Serial Poll

In the GG mask version, if the GPIA had been in the talker active state prior to the controller conducting a serial poll, it is possible for nba to be lost. The situation is as follows: if a byte of data has been written into R7W and the controller takes over the bus synchronously at SDYS (SH state diagram, Figure 3, page 20, IEEE-488 1978 Specification) to perform a serial poll, the GG mask version of the GPIA will respond in one of two ways.

- a) If the controller never requests the contents of the Serial Poll Register from the GPIA, and when the GPIA is returned as a talker, the data in R7W is available to the listeners on the bus.
 (Data byte is not destroyed)
- b) If the controller requests the contents of the Serial Poll Register from the active talker, when the controller returns the GPIA to the Active

Talker State, the data which was in R7W will have been handshaked as though it had been accepted by the active listeners (data byte will be destroyed).

The original IEEE Standard had a discrepancy as to what happens to this data byte (nba) under these circumstances. This discrepancy has been alleviated. The MH mask conforms to the latest revision and does not destroy the data in R7W when a Serial Poll occurs, i.e., if in TACS with a nba pending when the controller releases the bus to the talker, the byte in R7W will be transferred, via handshake, to the listeners (data byte is not destroyed)

SOFTWARE DIFFERENCES BETWEEN MASK SETS

The seven changes mentioned in the previous sections are the only changes from the GG to the MH mask set All of these changes except number 3 (TPAS and LPAS status bits) are transparent to the user software.

The change to TPAS and LPAS status bits is a functional change. In the GG mask, user software could monitor LPAS and TPAS for address recognition in the primary address mode because LPAS is set as soon as the GPIA receives its Listen Address (MLA) and TPAS is set as soon as the GPIA receives its Talker Address (MTA), i.e., the LPAS bit is set when the GPIA enters LADS and the TPAS bit is set when the GPIA enters LADS and the TPAS bit is set when the GPIA enters LADS and the MH mask set these bits do not report LADS/TADS and as such they can only be used in the extended address mode. In the primary address mode the software for the MH mask set should monitor LACS/TACS (bits 2 and 3 of the address status register) rather than LPAS/TPAS. TACS/LACS indicates when the device is in the Talker/Listener Active State.



MC68701 (1.0 MHz) MC68701-1 MC68B701 (1.25 MHz)

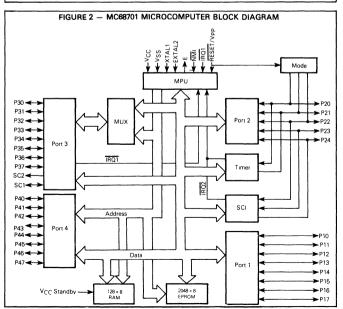
MC68A701 (1.5 MHz) (2.0 MHz)

Advance Information

MC68701 MICROCOMPUTER UNIT (MCU)

The MC68701 is an 8-bit single chip microcomputer unit (MCU) which significantly enhances the capabilities of the M6800 family of parts. It can be used in production systems to allow for easy firmware changes with minimum delay or it can be used to emulate the MC6801/03 for software development. It includes an upgraded M6800 microprocessor unit (MPU) with upward source and object code compatibility. Execution times of key instructions have been improved and several new instructions have been added including an unsigned multiply. The MCU can function as a monolithic microcomputer or can be expanded to a 64K byte address space. It is TTL compatible and requires one +5 volt power supply for nonprogramming operation. An additional Vpp power supply is needed for EPROM programming. On-chip resources include 2048 bytes of EPROM, 128 bytes of RAM, Serial Communications Interface (SCI), parallel I/O, and a three function Programmable Timer. A summary of MCU features includes:

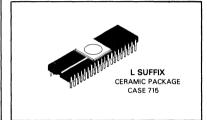
- Enhanced MC6800 Instruction Set
- 8×8 Multiply Instruction
- Serial Communications Interface (SCI)
- Upward Source and Object Code Compatibility with the MC6800
- 16-Bit Three-Function Programmable Timer
- Single-Chip or Expanded Operation to 64K Byte Address Space
- Bus Compatibility with the M6800 Family
- 2048 Bytes of UV Erasable, User Programmable ROM (EPROM)
- 128 Bytes of RAM (64 Bytes Retainable on Powerdown)
- 29 Parallel I/O and Two Handshake Control Lines
- Internal Clock Generator with Divide-by-Four Output

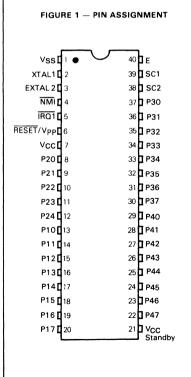


MOS

(N-CHANNEL, SILICON-GATE, DEPLETION LOAD)

MICROCOMPUTER WITH EPROM





MC68701+MC68A701+MC68701-1+MC68B701

MAXIMUM RATINGS

| Rating | Symbol | Value | Unit |
|-----------------------------|------------------|----------------|------|
| Supply Voltage | Vcc | -03 to +70 | V |
| Input Voltage | V _{in} | -0.3 to +7.0 | ٧ |
| Operating Temperature Range | TA | 0 to 70 | °C |
| Storage Temperature Range | T _{stg} | 0 to +85 | °C |

This device contains circuitry to protect the inputs against damage due to high static voltages or electric fields, however, it is advised that normal precautions be taken to avoid application of any voltage higher than maximum rated voltages to this high-impedance circuit. For proper operation it is recommended that V_{In} and V_{out} be constrained to the range $V_{SS} \leq (V_{in}$ or $V_{out}) \leq V_{CC}$ Reliability of operation is enhanced if unused inputs are tied to an appropriate logic voltage level (e.g., either V_{SS} or V_{CC})

THERMAL CHARACTERISTICS

| Characteristic | Symbol | Value | Rating |
|--------------------|---------------|-------|--------|
| Thermal Resistance | a | 50 | °C/W |
| Ceramic Package | θ_{JA} | 1 30 | C/ VV |

POWER CONSIDERATIONS

The average chip-junction temperature, T.J., in °C can be obtained from

$$T_{J} = T_{A} + (P_{D} \cdot \theta_{JA})$$

Where

T_A ≡ Ambient Temperature, °C

θJA≡ Package Thermal Resistance, Junction-to-Ambient, °C/W

PD = PINT + PPORT

PINT≡ICC×VCC, Watts - Chip Internal Power

PPORT = Port Power Dissipation, Watts - User Determined

For most applications $P_{PORT} \blacktriangleleft P_{INT}$ and can be neglected P_{PORT} may become significant if the device is configured to drive Darlington bases or sink LED loads

An approximate relationship between PD and TJ (if PPORT is neglected) is

$$P_D = K - (T_J + 273 ^{\circ}C)$$

(2)

(1)

Solving equations 1 and 2 for K gives

$$K = PD \bullet (TA + 273 \circ C) + \theta JA \bullet PD^2$$

(3)

Where K is a constant pertaining to the particular part. K can be determined from equation 3 by measuring P_D (at equilibrium) for a known T_A . Using this value of K the values of P_D and T_J can be obtained by solving equations (1) and (2) iteratively for any value of T_A .

CONTROL TIMING ($V_{CC} = 5.0 \text{ V } \pm 5\%$, $V_{SS} = 0$, $T_A = 0$ to 70°C)

| Ob | MC68701 | | MC68701-1 | | MC68A701 | | MC68B701 | | Unit | |
|----------------------------------|-----------------|-------|-----------|-------|----------|-------|----------|-------|------|------|
| Characteristic | Symbol | Min | Max | Min | Max | Min | Max | Min | Max | Unit |
| Frequency of Operation | fo | 05 | 10 | 05 | 1 25 | 05 | 15 | 05 | 20 | MHz |
| Crystal Frequency | fXTAL | 3 579 | 4 0 | 3 579 | 50 | 3 579 | 60 | 3 579 | 80 | MHz |
| External Oscillator Frequency | 4f _O | 20 | 4 0 | 20 | 50 | 20 | 60 | 20 | 80 | MHz |
| Crystal Oscillator Start Up Time | t _{rc} | _ | 100 | - | 100 | - | 100 | - | 100 | ms |
| Processor Control Setup Time | tPCS | 200 | _ | 170 | | 140 | _ | 110 | | ns |

MC68701 • MC68A701 • MC68701-1 • MC68B701

DC ELECTRICAL CHARACTERISTICS ($V_{CC} = 5.0 \text{ Vdc} \pm 5\%$, $V_{SS} = 0$, $T_A = 0$ to 70°C unless otherwise noted)

| | Characteristic | | Symbol | Min | Тур | Max | Unit |
|--|------------------------------|--|-------------------------------------|---|-----------|--|------|
| Input High Voltage | | RESET Other Inputs* | VIH | V _{SS} +40 V _{SS} +20 | - | V _{CC} V _{CC} | ٧ |
| Input Low Voltage | | RESET Other Inputs* | VIL | V _{SS} -03 V _{SS} -03 | - | V _{SS} +04 V _{SS} +08 | ٧ |
| Input Current (V _{In} = 0 to 2 4 V) | See Note | Port 4 SC1 | 1 _{in} | - | _ | 0 6 1 0 | mA |
| Input Current (V _{In} = 0 to 5 25 V) | | NMI, IRQ1 | 1 _{in} | - | 15 | 2 5 | μΑ |
| Input Current (V _{In} = 0 to 0 4 V) (V _{In} = 4 0 V to V _{CC}) | See Note | RESET/V _{PP} | l _{in} | - - | -20 - | - 8 0 | mA |
| Three-State (Off State) Input Cur (V _{In} = 0 5 to 2 4 V) | rent | P10-P17, P30-P37 P20-P24 | ITSI | _ | 2 10 0 | 10 100 | μΑ |
| Output High Voltage $ \begin{aligned} &(I_{load} = -205\mu\text{A},\text{V}_{CC} = \text{min}) \\ &(I_{load} = -145\mu\text{A},\text{V}_{CC} = \text{min}) \\ &(I_{load} = -100\mu\text{A},\text{V}_{CC} = \text{min}) \end{aligned} $ | | P30-P37 P40-P47, E, SC1, SC2 Other Outputs | Voн | V _{SS} +24 V _{SS} +24 V _{SS} +24 | | _ _ _ | ٧ |
| Output Low Voltage (I _{load} = 2 0 mA, V _{CC} = min) | | All Outputs | VOL | _ | - | V _{SS} +05 | V |
| Darlington Drive Current (V _O = 1 5 V) | | P10-P17 | ЮН | 10 | 25 | 10 0 | mA |
| Internal Power Dissipation (measing | ured at TA = 0°C in S | teady-State Operation) | PINT | - | _ | 1500 | mW |
| Input Capacitance $(V_{IN} = 0, T_A = 25^{\circ}C, f_O = 1.0 \text{ MHz}$ | łz) | P30-P37, P40-P47, SC1 Other Inputs | C _{in} | | | 12 5 10 0 | pF |
| V _{CC} Standby | | Powerdown Powerup | V _{SBB} V _{SB} | 4 0 4 75 | | 5 25 5 25 | ٧ |
| Standby Current | | Powerdown | ISBB | _ | - | 60 | mA |
| Programming Time (Per Byte) (T, | | | tpp | 25 | | 50 | ms |
| Programming Voltage (TA = 25°C |) | | Vpp | 20 0 | 21 0 | 22 0 | ٧ |
| Programming Current (VRESET= | Vpp) (T _A = 25°C) | | IPP | _ | 30 0 | 50 0 | mA |

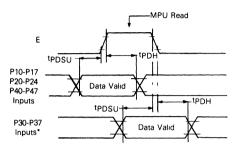
^{*}Except Mode Programming Levels, See Figure 17

NOTE Port 4, SC1, and RESET/VPP I_{In} differ from MC6801/03/03 NR Values

PERIPHERAL PORT TIMING (Refer to Figures 3-6)

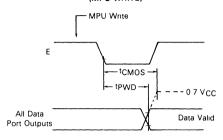
| Characteristics | Symbol | Mın | Тур | Max | Unit |
|---|------------------|-----|-----|------------|------|
| Peripheral Data Setup Time | tPDSU | 200 | - | - | ns |
| Peripheral Data Hold Time | t _{PDH} | 200 | | - | ns |
| Delay Time, Enable Positive Transition to OS3 Negative Transition | tOSD1 | | | 350 | ns |
| Delay Time, Enable Positive Transition to OS3 Positive Transition | tOSD2 | - | - | 350 | ns |
| Delay Time, Enable Negative Transition to Peripheral Data Valid Port 1 Port 2, 3, 4 | tPWD | - | | 350 350 | ns |
| Delay Time, Enable Negative Transition to Peripheral CMOS Data Valid | tCMOS | - | - | 2 0 | μS |
| Input Strobe Pulse Width | tPWIS | 200 | | - | ns |
| Input Data Hold Time | tін | 50 | _ | - | ns |
| Input Data Setup Time | tis | 20 | _ | - | ns |

FIGURE 3 — DATA SETUP AND HOLD TIMES (MPU READ)



*Port 3 Non-Latched Operation (LATCH ENABLE = 0)

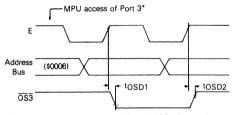
FIGURE 4 - DATA SETUP AND HOLD TIMES (MPU WRITE)



NOTES

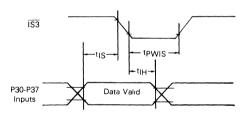
- 1 10 k Pullup resistor required for Port 2 to reach 0.7 V_{CC}
- 2 Not applicable to P21
- 3 Port 4 cannot be pulled above V_{CC}

FIGURE 5 - PORT 3 OUTPUT STROBE TIMING (SINGLE-CHIP MODE)



*Access matches Output Strobe Select (OSS = 0, a read, OSS = 1, a write)

FIGURE 6 - PORT 3 LATCH TIMING (SINGLE-CHIP MODE)



NOTE Timing measurements are referenced to a low voltage of 0.8 volts and a high voltage of 2.0 volts unless otherwise noted

FIGURE 7 — CMOS LOAD

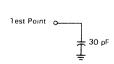
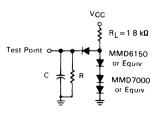


FIGURE 8 - TIMING TEST LOAD PORTS 1, 2, 3, 4



C = 90 pF for P30-P37, P40-P47, E, SC1, SC2 = 30 pF for P10-P17, P20-P24

 $R=16.5~k\Omega$ for P40-P47, E, SC1, SC2

= 24 k Ω for P10-P17, P20-P24

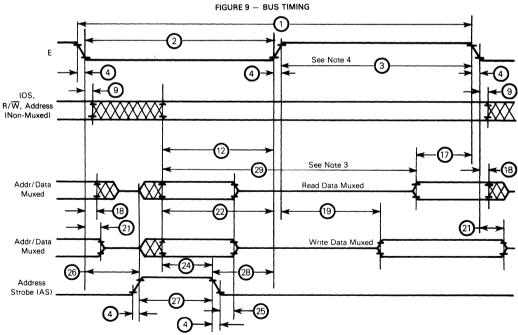
= 12 k Ω for P30-P37

BUS TIMING (See Notes 2 and 3)

| Ident | Characteristic | Symbol | MC68701 | | MC68 | 3701-1 | MC68A701 | | MC68B701 | | Unit |
|--------|--|---------------------------------|---------|------|------|--------|----------|------|----------|------|------|
| Number | Characteristic | Symbol | Mın | Max | Min | Max | Min | Max | Min | Max | Unit |
| 1 | Cycle Time | t _{cyc} | 10 | 20 | 0.8 | 20 | - | 20 | 05 | 20 | μS |
| 2 | Pulse Width, E Low | PWEL | 430 | 1000 | 360 | 1000 | 300 | 1000 | 210 | 1000 | ns |
| 3 | Pulse Width, E High | PWEH | 450 | 1000 | 360 | 1000 | 300 | 1000 | 220 | 1000 | ns |
| 4 | Clock Rise and Fall Time | t _r , t _f | - | 25 | - | 25 | - | 25 | _ | 20 | ns |
| 9 | Address Hold Time | t _A H | 20 | | 20 | - | 20 | - | 10 | - | ns |
| 12 | Non-Muxed Address Valid Time to E* | tAV | 200 | _ | 150 | - | 115 | - | 70 | | ns |
| 17 | Read Data Setup Time | tDSR | 80 | _ | 70 | - | 60 | - | 40 | - | ns |
| 18 | Read Data Hold Time | ^t DHR | 10 | _ | 10 | - | 10 | - | 10 | - | ns |
| 19 | Write Data Delay Time | tDDW | _ | 225 | - | 200 | - | 170 | - | 120 | ns |
| 21 | Write Data Hold Time | tDHW | 20 | - | 20 | - | 20 | - | 10 | - | ns |
| 22 | Multiplexed Address Valid Time to E Rise* | tAVM | 200 | | 150 | - | 115 | - | 80 | _ | ns |
| 24 | Multiplexed Address Valid Time to AS Fall* | tASL | 60 | _ | 50 | - | 40 | - | 20 | _ | ns |
| 25 | Multiplexed Address Hold time | tAHL | 20 | - | 20 | - | 20 | - | 10 | _ | ns |
| 26 | Delay Time, E to AS Rise* | tASD | 90** | _ | 70** | - | 60** | _ | 45** | _ | ns |
| 27 | Pulse Width, AS High* | | 220 | - | 170 | - | 140 | _ | 110 | _ | ns |
| 28 | Delay Time, AS to E Rise* | tASED | 90 | _ | 70 | - | 60 | - | 45 | _ | ns |
| 29 | Usable Access Time* | tACC | 595 | _ | 465 | - | 380 | - | 270 | _ | ns |

^{*}At specified cycle time

^{**}tASD parameters listed assume external TTL clock drive with 50% ±5% duty cycle. Devices driven by an external TTL clock with 50% ±1% duty cycle or which use a crystal have the following tASD specification 100 ns min (1 0 HMz devices), 80 ns min (1 25 MHz devices), 65 ns min (1 5 MHz devices), 50 ns min (2 0 MHz devices)



NOTES

- 1 Voltage levels shown are V_l \leq 0 5 V, V_H \geq 2 4 V, unless otherwise specified 2 Measurement points shown are 0 8 V and 2 0 V, unless otherwise specified
- 3 Usable access time is computed by 12+3-17+4
- 4 Memory devices should be enabled only during E high to avoid Port 3 bus contention

INTRODUCTION

The MC68701 is an 8-bit monolithic microcomputer which can be configured to function in a wide variety of applications. The facility which provides this extraordinary flexibility is its ability to be hardware programmed into eight different operating modes. The operating mode controls the configuration of 18 of the 40 MCU pins, available on-chip resources, memory map, location (internal or external) of interrupt vectors, and type of external bus. The configuration of the remaining 22 pins is not dependent on the operating mode.

Twenty-nine pins are organized as three 8-bit ports and one 5-bit port. Each port consists of at least a Data Register and a write-only Data Direction Register. The Data Direction Register is used to define whether corresponding bits in the Data Register are configured as an input (clear) or output (set).

The term "port," by itself, refers to all of the hardware associated with the port. When the port is used as a "data port" or "I/O port," it is controlled by the port Data Direction Register and the programmer has direct access to the port pins using the port Data Register. Port pins are labled as Pij where i identifies one of four ports and j indicates the particular bit.

The Microprocessor Unit (MPU) is an enhanced MC6800 MPU with additional capabilities and greater throughput It is upward source and object code compatible with the MC6800. The programming model is depicted in Figure 10

where Accumulator D is a concatenation of Accumulators A and B. A list of new operations added to the M6800 instruction set are shown in Table 1.

The basic difference between the MC6801 and the MC68701 is that the MC6801 has an onboard ROM while the MC68701 has an onboard EPROM. The MC68701 is pin and code compatible with the MC6801 and can be used to emulate the MC6801, allowing easy software development using the onboard EPROM. Software developed using the MC68701 can then be masked into the MC6801 ROM.

In order to support the onboard EPROM, the MC68701 differs from the MC6801 as follows

- (1) Mode 0 in the MC6801 is a test mode only, while in the MC68701 Mode 0 is also used to program the onboard EPROM and has interrupt vectors at \$BFF0-\$BFFF rather than \$FFF0-\$FFFF
- (2) The MC68701 RAM/EPROM Control Register has two bits used to control the EPROM in Mode 0 that are not defined in the MC6801 RAM Control Register
- (3) The RESET/Vpp pin in the MC68701 is dual purpose, used to supply EPROM power as well as to reset the device, while in the MC6801 the pin is called RESET and is used only to reset the device

In addition, MC6801 modes 1R and 6R, available as a mask option, are not available in the MC68701

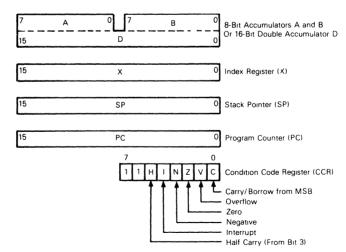


FIGURE 10 - MC68701/6801/6803 PROGRAMMING MODEL

TABLE 1 - NEW INSTRUCTIONS

| Instruction | Description |
|--------------|---|
| ABX | Unsigned addition of Accumulator B to Index Register |
| ADDD | Adds (without carry) the double accumulator to memory and leaves the sum in the double accumulator |
| ASLD or LSLD | Shifts the double accumulator left (towards MSB) one bit, the LSB is cleared and the MSB is shifted into the C-bit |
| BHS | Branch if Higher or Same, unsigned conditional branch (same as BCC) |
| BLO | Branch if Lower, Unsigned conditional branch (same as BCS) |
| BRN | Branch Never |
| JSR | Additional addressing mode direct |
| LDD | Loads double accumulator from memory |
| LSL | Shifts memory or accumulator left (towards MSB) one bit, the LSB is cleared and the MSB is shifted into the C-bit (same as ASL) |
| LSRD | Shifts the double accumulator right (towards LSB) one bit, the MSB is cleared and the LSB is shifted into the C-bit |
| MUL | Unsigned multiply, multiplies the two accumulators and leaves the product in the double accumulator |
| PSHX | Pushes the Index Register to stack |
| PULX | Pulls the Index Register from stack |
| STD | Stores the double accumulator to memory |
| SUBD | Subtracts memory from the double accumulator and leaves the difference in the double accumulator |
| CPX | Internal processing modified to permit its use with any conditional branch instruction |

OPERATING MODES

The MCU provides eight different operating modes which are selectable by hardware programming and referred to as Mode 0 through Mode 7. The operating mode controls the memory map, configuration of Port 3, Port 4, SC1, SC2, and the physical location of interrupt vectors.

FUNDAMENTAL MODES

The eight MCU modes can be grouped into three fundamental modes which refer to the type of bus it supports: Single Chip, Expanded Non-Multiplexed, and Expanded Multiplexed. Modes 4 and 7 are single chip modes. Mode 5 is the expanded non-multiplexed mode, and the remaining modes are expanded multiplexed modes Table 2 summarzes the characteristics of the operating modes

Single-Chip Modes (4, 7)

In the Single-Chip Mode, the four MCU ports are configured as parallel input/output data ports, as shown in Figure 11. The MCU functions as a monolithic microcomputer in these two modes without external address or data buses. A maximum of 29 I/O lines and two Port 3 control lines are provided. Peripherals or another MCU can be interfaced to Port 3 in a loosely coupled dual processor configuration, as shown in Figure 12.

In Single-Chip Test Mode (4), the RAM responds to \$XX80 through \$XXFF and the EPROM is removed from the internal address map. A test program must first be loaded into the RAM using modes 0, 1, 2, or 6. If the MCU is reset and then programmed into Mode 4, execution will begin at \$XXFE:XXFF Mode 5 can be irreversibly entered from Mode 4 without asserting RESET by setting bit 5 of the Port 2 Data Register. This mode is used primarily to test Ports 3 and 4 in the Single-Chip and Non-Multiplexed Modes

TABLE 2 - SUMMARY OF MC68701 OPERATING MODES

Common to all Modes:

Reserved Register Area

Port 1

Port 2

Programmable Timer

Serial Communications Interface

Single Chip Mode 7

128 bytes of RAM; 2048 bytes of EPROM

Port 3 is a parallel I/O port with two control lines

Port 4 is a parallel I/O port

SC1 is Input Strobe 3 (IS3) SC2 is Output Strobe 3 (OS3)

Expanded Non-Multiplexed Mode 5

128 bytes of RAM, 2048 bytes of EPROM

256 bytes of external memory space

Port 3 is an 8-bit data bus

Port 4 is an input port/address bus

SC1 is Input/Output Select (IOS)

SC2 is Read/Write (R/W)

Expanded Multiplexed Modes 1, 2, 3, 6

Four memory space options (64K address space)

- (1) No internal RAM or EPROM (Mode 3)
- (2) Internal RAM, no EPROM (Mode 2)
- (3) Internal RAM and EPROM (Mode 1)
- (4) Internal RAM, EPROM with partial address bus (Mode 6)

Port 3 is a multiplexed address/data bus

Port 4 is an address bus (inputs/address in Mode 6)

SC1 is Address Strobe (AS)

SC2 is Read/Write (R/W)

Test Mode 4

- (1) May be changed to Mode 5 without going through Reset
- (2) May be used to test Ports 3 and 4 as I/O ports

Expanded Multiplexed Mode 0

- (1) Internal RAM and EPROM
- (2) External interrupt vectors located at \$BFF0-\$BFFF
- (3) Used to program EPROM

FIGURE 11 - SINGLE-CHIP MODE

FIGURE 12 - SINGLE-CHIP DUAL PROCESSOR CONFIGURATION

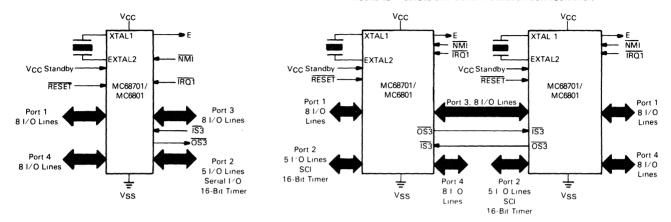
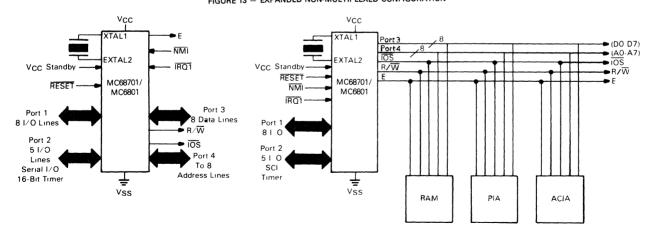


FIGURE 13 — EXPANDED NON-MULTIPLEXED CONFIGURATION



Expanded Non-Multiplexed Mode (5)

A modest amount of external memory space is provided in the Expanded Non-Multiplexed Mode while significant onchip resources are retained. Port 3 functions as an 8-bit bidirectional data bus and Port 4 is configured initially as input data port. Any combination of the eight least-significant address lines may be obtained by writing to the Port 4 Data Direction Register. Stated alternatively, any combination of A0 to A7 may be provided while retaining the remainder as input data lines. Internal pullup resistors are intended to pull the Port 4 lines high until the port is configured.

Figure 13 illustrates a typical system configuration in the Expanded Non-Multiplexed Mode. The MCU interfaces directly with M6800 family parts and can access 256 bytes of external address space at \$100 through \$1FF. IOS provides an address decode of external memory (\$100-\$1FF) and can be used as a memory page select or chip select line

Expanded-Multiplexed Modes (0, 1, 2, 3, 6)

In the Expanded-Multiplexed Modes, the MCU has the ability to access a 64K byte memory space. Port 3 functions as a time multiplexed address/data bus with address valid on the negative edge of Address Strobe (AS), and data valid while E is high. In Modes 0 to 3, Port 4 provides address lines A8 to A15. In Mode 6, however, Port 4 is initially configured at RESET as an input data port. The Port 4 Data Direction Register can then be changed to provide any combination of address lines, A8 to A15. Stated alternatively, any subset of A8 to A15 can be provided while retaining the remaining Port 4 lines as input data lines. Internal pullup resistors pull the Port 4 lines high until software configures the port.

Figure 14 depicts a typical configuration for the Expanded-Multiplexed Modes. Address Strobe can be used to control a transparent D-type latch to capture addresses A0 to A7, as shown in Figure 15. This allows Port 3 to function as a Data Bus when E is high

In Mode 0, the internal and external data buses are connected, there must therefore be no memory map overlap in order to avoid potential bus conflicts. Mode 0 is used to program the onboard EPROM. All interrupt vectors are external in this mode and are located at \$BFFO-8BFFF.

PROGRAMMING THE MODE

The operating mode is determined at RESET by the levels asserted on P22, P21, and P20. These levels are latched into PC2, PC1, and PC0 of the program control register on the positive edge of RESET. The operating mode may be read from the Port 2 Data Register as shown below, and programing levels and timing must be met as shown in Figure 16. A brief outline of the operating modes is shown in Table 3.

| PORT 2 DATA REGISTER | | | | | | | | | | | |
|----------------------|-----|-----|-----|-----|-----|-----|-----|-----|--------|--|--|
| | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | | | |
| | PC2 | PC1 | PC0 | P24 | P23 | P22 | P21 | P20 | \$0003 | | |

Circuitry to provide the programming levels is dependent primarily on the normal system usage of the three pins. If configured as outputs, the circuit shown in Figure 17 may be used, otherwise, three-state buffers can be used to provide isolation while programming the mode.

MEMORY MAPS

The MCU can provide up to 64K byte address space depending on the operating mode A memory map for each operating mode is shown in Figure 18. The first 32 locations of each map are reserved for the MCU internal registers as shown in Table 4, with exceptions as indicated

TABLE 3 - MODE SELECTION SUMMARY

| Mode | P22 PC2 | P21 PC1 | P20 PC0 | EPROM | RAM | Interrupt Vectors | Bus Mode | Operating Mode |
|------|------------|------------|------------|-------|------|----------------------|------------------------|--------------------------------|
| 7 | н | н | н | 1 | - | 1 | 1 | Single Chip |
| 6 | Н | Н | L | 1 | 1 | 1 | MUX ^(5, 6) | Multiplexed/Partial Decode |
| 5 | н | L | н | l i | - | 1 | NMUX ^(5, 6) | Non-Multiplexed/Partial Decode |
| 4 | н | L | L | 1(2) | J(1) | I | 1 | Single Chip Test |
| 3 | L | Н | Н | E | E | E | MUX ⁽⁴⁾ | Multiplexed/No RAM or EPROM |
| 2 | L | н | L | E | 1 | E | MUX ⁽⁴⁾ | Multiplexed/RAM |
| 1 | L | L | н | 1 | ı | E | MUX ⁽⁴⁾ | Multiplexed/RAM and EPROM |
| 0 | L | L | L | 1 | 1 | (3) | MUX ⁽⁴⁾ | Multiplexed/Programming |

Legend

I - Internal

E — External

MUX — Multiplexed

NMUX - Non-Multiplexed

L — Logic "0"

H - Logic "1"

Notes

- (1) Internal RAM is addressed at \$XX80
- (2) Internal EPROM is disabled
- (3) Interrupt vectors located at \$BFF0-\$BFFF
- (4) Addresses associated with Ports 3 and 4 are considered external in Modes 0,
- (5) Addresses associated with Port 3 are considered external in Modes 5 and 6
- (6) Port 4 default is user data input, address output is optional by writing to Port 4 Data Direction Register

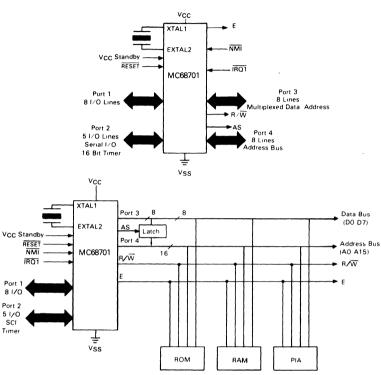


FIGURE 14 - EXPANDED MULTIPLEXED CONFIGURATION

NOTE To avoid data bus (Port 3) contention in the expanded multiplexed modes, memory devices should be enabled only during E high time

FIGURE 15 — TYPICAL LATCH ARRANGEMENT

AS

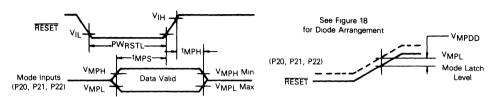
Port 3
Address/Data

Address A₀-A₇

Data D₀-D₇

4-864

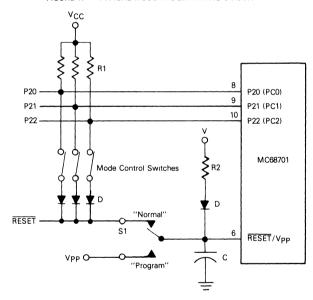
FIGURE 16 - MODE PROGRAMMING TIMING



MODE PROGRAMMING (Refer to Figure 16)

| Characteristic | Symbol | Min | Тур | Max | Unit |
|--|------------------|----------|-----|-----|----------|
| Mode Programming Input Voltage Low | VMPL | _ | - | 18 | V |
| Mode Programming Input Voltage High | VMPH | 40 | - | _ | V |
| Mode Programming Diode Differential | VMPDD | 0.6 | - | _ | V |
| RESET Low Pulse Width | PWRSTL | 30 | _ | | E-Cycles |
| Mode Programming Set-Up Time | tMPS | 20 | | | E-Cycles |
| Mode Programming Hold Time RESET Rise Time≥1 μs RESET Rise Time<1 μs | [†] MPH | 0 100 | - | _ | ns |

FIGURE 17 - TYPICAL MODE PROGRAMMING CIRCUIT



Notes.

- 1 Mode 0 as shown (switches closed)
- 2 R1 = 10k ohms (typical)
- 3 The RESET time constant is equal to RC where R is the equivalent parallel resistance of R2 and the number of resistors (R1) placed in the circuit by closed mode control switches
- 4 D = 1N914, 1N4001 (typical)
- The North National Research Re

- Switch ST allows selection of Indian Reservor programming (vpp) as the input to the Reservor print Stating switching, the input level is held at a value determined by a diode (D), resistor (R2) and input voltage (V)
 While S1 is in the "Program" position, RESET should not be asserted
 From powerup, RESET must be held low for at least tRC. The capacitor, C, is shown for conceptual purposes only and is on the order of 1000 μF for the circuit shown. Typically, a buffer with an RC input will be used to drive RESET, eliminating. the need for the larger capacitor
- 9 Diode Vf should not exceed VMPDD min

FIGURE 18 - MC68701 MEMORY MAPS

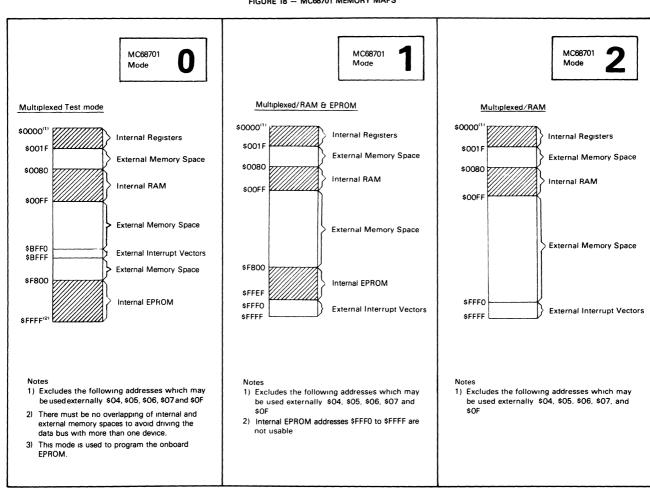
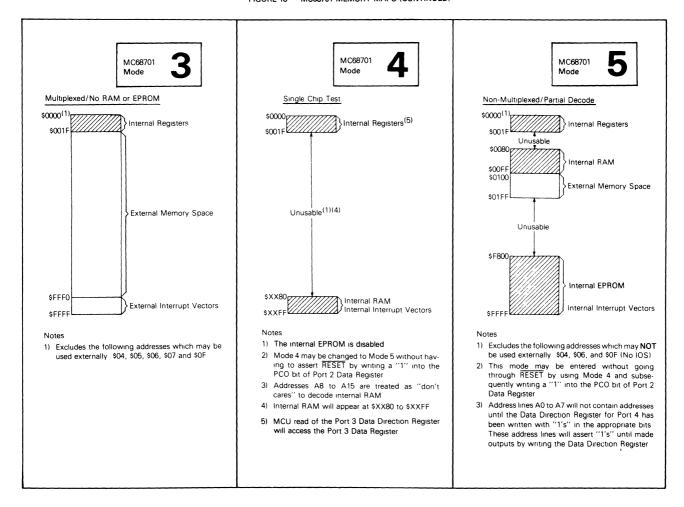


FIGURE 18 - MC68701 MEMORY MAPS (CONTINUED)



MC68701 MC68701 Mode Mode Multiplexed/Partial Decode Single Chip \$00000 \$000001 Internal Registers⁽¹⁾ Internal Registers \$001F \$001F External Memory Space Unusable \$0080 \$0080 Internal RAM Internal RAM \$00FF Unusable External Memory Space \$F800 \$F800 Internal EPROM Internal EPROM Internal Interrupt Vectors Internal Interrupt Vectors Note Notes 1) MCU read of the Port 3 Data Direction Register will access the Port 3 Data Register 1) Excludes the following addresses which may be used externally \$04, \$06, \$0F 2) Address lines A8-A15 will not contain addresses until the Data Direction Register for Port 4 has been written with "1's" in the appropriate bits. These address lines will assert "1's" until made outputs by writing the **Data Direction Register**

FIGURE 18 - MC68701 MEMORY MAPS (CONCLUDED)

TABLE 4 - INTERNAL REGISTER AREA

| Register | Address | |
|---|----------------------------|--|
| Port 1 Data Direction Register *** Port 2 Data Direction Register *** Port 1 Data Register Port 2 Data Register | 00 01 02 03 | Output (Input Ca Input Ca Port 3 C |
| Port 3 Data Direction Register *** Port 4 Data Direction Register *** Port 3 Data Register Port 4 Data Register | 04* 05** 06* 07** | Rate and Transmit Receive Transmit |
| Timer Control and Status Register Counter (High Byte) Counter (Low Byte) Output Compare Register (High Byte) | 08 09 0A 0B | RAM/EP Reserved |

| Register | Address |
|---|----------------------|
| Output Compare Register (Low Byte) | oc |
| Input Capture Register (High Byte) | OD |
| Input Capture Register (Low Byte) | 0E |
| Port 3 Control and Status Register | OF* |
| Rate and Mode Control Register Transmit/Receive Control and Status Register Receive Data Register Transmit Data Register | 10 11 12 13 |
| RAM/EPROM Control Register Reserved | 14 15-1F |

^{*}External addresses in Modes 0, 1, 2, 3, 5, 6, cannot be accessed

in Mode 5 (No IOS)

^{**}External addresses in Modes 0, 1, 2, 3

^{***1 =} Output, 0 = Input

MC68701 INTERRUPTS

The MCU supports two types of interrupt requests maskable and non-maskable. A Non-Maskable Interrupt (\overline{NMI}) is always recognized and acted upon at the completion of the current instruction. Maskable interrupts are controlled by the Condition Code Register's I-bit and by individual enable bits. The I-bit controls all maskable interrupts. Of the maskable interrupts, there are two types. $\overline{IRQ1}$ and $\overline{IRQ2}$. The Programmable Timer and Senal Communications Interface use an internal $\overline{IRQ2}$ interrupt line, as shown in Figure 2. External devices (and $\overline{IS3}$) use $\overline{IRQ1}$. An $\overline{IRQ1}$ interrupt is serviced before $\overline{IRQ2}$ if both are pending

All IRO2 interrupts use hardware prioritized vectors. The single SCI interrupt and three timer interrupts are serviced in a prioritized order and each is vectored to a separate location. All MCU interrupt vector locations are shown in Table 5.

TABLE 5 - MCU INTERRUPT VECTOR LOCATIONS

| Mod | Mode 0 | | es 1-7 | |
|------|--------|------|------------------------------|---------------------------|
| MSB | LSB | MSB | LSB | Interrupt |
| BFFE | BFFF | FFFE | FFFF | RESET |
| BFFC | BFFD | FFFC | FFFD | NMI |
| BFFA | BFFB | FFFA | FFFB | Software Interrupt (SWI) |
| BFF8 | BFF9 | FFF8 | FFF9 | IRQ1 (or IS3) |
| BFF6 | BFF7 | FFF6 | FFF7 | ICF (Input Capture) * |
| BFF4 | BFF5 | FFF4 | FFF5 | OCF (Output Compare)* |
| BFF2 | BFF3 | FFF2 | FFF2 FFF3 TOF (Timer Overflo | |
| BFF0 | BFF1 | FFF0 | FFF1 | SCI (RDRF + ORFE + TDRE)* |

^{*}IRQ2 Interrupt

The Interrupt flowchart is depicted in Figure 19 and is common to every MCU interrupt excluding reset. During interrupt servicing the Program Counter, Index Register, A Accumulator, B Accumulator, and Condition Code Register are pushed to the stack. The I-bit is set to inhibit maskable interrupts and a vector is fetched corresponding to the current highest priority interrupt. The vector is transferred to the Program Counter and instruction execution is resumed. Interrupt and RESET timing are illustrated in Figures 20 and 21.

FUNCTIONAL PIN DESCRIPTIONS

VCC AND VSS

VCC and VSS provide power to a large portion of the MCU. The power supply should provide ± 5 volts ($\pm 5\%$) to VCC, and VSS should be tied to ground Total power dissipation (including VCC Standby), will not exceed PD milliwatts

VCC STANDBY

VCC Standby provides power to the standby portion (\$80 through \$BF) of the RAM and the STBY PWR and RAME bits of the RAM Control Register Voltage requirements depend on whether the MCU is in a powerup or powerdown state. In the powerup state, the power supply should provide +5 volts (±5%) and must reach VSB volts before RESET reaches 4.0 volts During powerdown, VCC Standby must remain above VSBB (min) to sustain the standby RAM and STBY PWR bit While in powerdown operation, the standby current will not exceed ISBB.

It is typical to power both V $_{CC}$ and V $_{CC}$ Standby from the same source during normal operation. A diode must be used between them to prevent supplying power to V $_{CC}$ during powerdown operation. V $_{CC}$ Standby should be tied to ground in Mode 3

XTAL1 AND EXTAL2

These two input pins interface either a crystal or TTL compatible clock to the MCU internal clock generator. Divide-by-four circuitry is included which allows use of the inexpensive 3.58 MHz or 4 4336 MHz Color Burst TV crystals A 20 pF capacitor should be tied from each crystal pin to ground to ensure reliable startup and operation. Alternatively, EXTAL2 may be driven by an external TTL compatible clock at $4f_0$ with a duty cycle of 50% ($\pm\,5\%$) with XTAL1 connected to ground

The internal oscillator is designed to interface with an AT-cut quartz crystal resonator operated in parallel resonance mode in the frequency range specified for fXTAL. The crystal should be mounted as close as possible to the input pins to minimize output distortion and startup stabilization time.** The MCU is compatible with most commercially available crystals. Nominal crystal parameters are shown in Figure 22.

RESET/VPP

This input is used to reset the MCU internal state and provide an orderly startup procedure. During powerup, \overline{RESET} must be held below 0.4 volts: (1) at least t_{RC} after V_{CC} reaches 4.75 volts in order to provide sufficient time for the clock generator to stabilize, and (2) until V_{CC} Standby reaches V_{SB} volts. \overline{RESET} must be held low at least three E-cycles if asserted during powerup operation.

This pin is also used to supply Vpp in Mode 0 for programming the EPROM, and supplies operating power to the EPROM during powerup operation

E (ENABLE)

This is an output clock used primarily for bus synchronization. It is TTL compatible and is the slightly skewed divideby-four result of the MCU input clock frequency. It will drive one Schottky TTL load and 90 pF, and all data given in cycles is referenced to this clock unless otherwise noted.

NMI (NON-MASKABLE INTERRUPT)

An $\overline{\text{NM}}$ negative edge requests an MCU interrupt sequence, but the current instruction will be completed before it responds to the request. The MCU will then begin an interrupt sequence. Finally, a vector is fetched from \$FFFC and \$FFFD (or \$BFFC and \$BFFD in Mode 0), transferred to the Program Counter and instruction execution is resumed. $\overline{\text{NM}}$ typically requires a 3 3 k Ω (nominal) resistor to V_{CC} . There is no internal $\overline{\text{NM}}$ pullup resistor. $\overline{\text{NM}}$ must be held low for at least one E-cycle to be recognized under all conditions.

IRQ1 (MASKABLE INTERRUPT REQUEST 1)

IRQ1 is a level-sensitive input which can be used to request an interrupt sequence. The MPU will complete the current instruction before it responds to the request. If the inter-

^{**}Devices made with masks subsequent to T7A and CB4 incorporate an advanced clock with improved startup characteristics

FIGURE 19 - INTERRUPT FLOWCHART

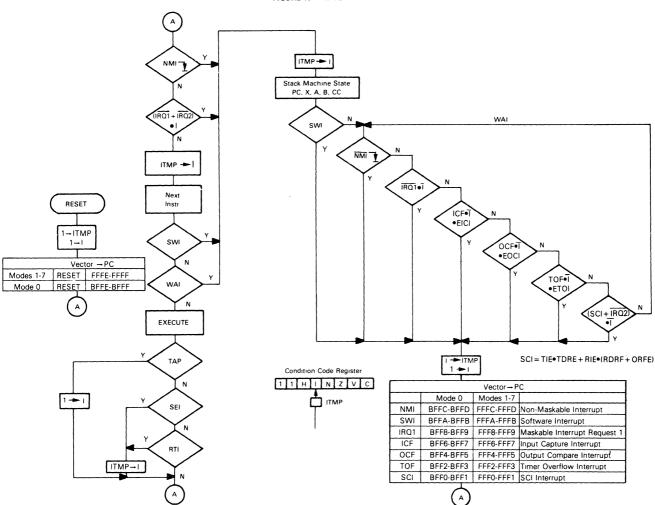


FIGURE 20 - INTERRUPT SEQUENCE

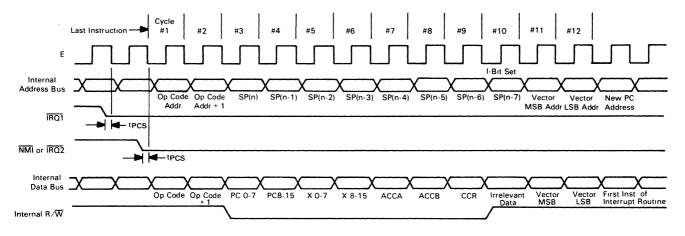
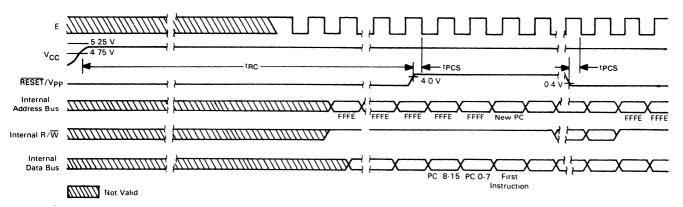


FIGURE 21 - RESET TIMING



rupt mask bit (I-bit) in the Condition Code Register is clear, the MCU will begin an interrupt sequence. A vector is fetched from \$FFF8 and \$FFF9 (or \$BFF8 and \$BFF9 in Mode 0), transferred to the Program Counter, and instruction execution is resumed.

 $\overline{IRQ1}$ typically requires an external 3.3 k Ω (nominal) resistor to VCC for wire-OR applications $\overline{IRQ1}$ has no internal pullup resistor

SC1 AND SC2 (STROBE CONTROL 1 AND 2)

The function of SC1 and SC2 depends on the operating mode SC1 is configured as an output in all modes except single chip mode, whereas SC2 is always an output SC1 and SC2 can drive one Schottky load and 90 pF

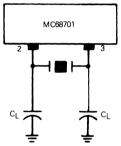
SC1 and SC2 In Single Chip Mode

In Single Chip Mode, SC1 and SC2 are configured as an input and output, respectively, and both function as Port 3 control lines SC1 functions as $\overline{\text{IS3}}$ and can be used to indicate that Port 3 input data is ready or output data has been accepted. Three options associated with $\overline{\text{IS3}}$ are controlled by the Port 3 Control and Status Register and are discussed in the Port 3 description. If unused, $\overline{\text{IS3}}$ can remain unconnected.

SC2 is configured as $\overline{OS3}$ and can be used to strobe output data or acknowledge input data. It is controlled by Output Strobe Select (OSS) in the Port 3 Control and Status Register. The strobe is generated by a read (OSS=0) or write (OSS=1) to the Port 3 Data Register. $\overline{OS3}$ timing is shown in Figure 5

FIGURE 22 - MC68701 OSCILLATOR CHARACTERISTICS

(a) Nominal Recommended Crystal Parameters



CL = 20 pF (typical)

NOTE

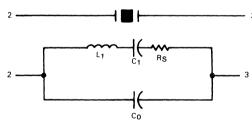
TTL-compatible oscillators may be obtained from

Motorola Component Products
Attn Data Clock Sales
2553 N Edginton St
Franklin Park, IL 60131
Tel 312-451-1000
Telex 433-0067

MC68701 Nominal Crystal Parameters

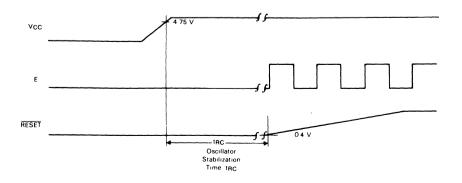
| | | | 141000101110 | ······································ | | |
|---|----------------|----------|--------------|--|--------------|--------------|
| Ì | | 3.58 MHz | 4.00 MHz | 5.0 MHz | 6.0 MHz | 8.0 MHz |
| i | RS | 60 Ω | 50 Ω | 30-50 Ω | 30-50 Ω | 20-40 Ω |
| ĺ | C ₀ | 35 pF | 65pF | 4 6 pF | 4-6 pF | 46 pF |
| i | C ₁ | 0 015 pF | 0 025 pF | 0 01-0 02 pF | 0 01-0 02 pF | 0 01-0 02 pF |
| į | Q | >40 k | >30 k | > 20 k | >20 k | >20 k |

 Note These are representative AT-cut crystal parameters only. Crystals of other types of cuts may also be used



Equivalent Circuit

(b) Oscillator Stabilization Time (tpc)



SC1 And SC2 In Expanded Non-Multiplexed Mode

In the Expanded Non-Multiplexed Mode, both SC1 and SC2 are configured as outputs SC1 functions as Input/Output Select (IOS) and is asserted only when \$0100 through \$01FF is sensed on the internal address bus

SC2 is configured as Read/Write and is used to control the direction of data bus transfers. An MPU read is enabled when Read/Write and E are high

SC1 And SC2 In Expanded Multiplexed Mode

In the Expanded Multiplexed Modes, both SC1 and SC2 are configured as outputs SC1 functions as Address Strobe and can be used to demultiplex the eight least significant addresses and the data bus A latch controlled by Address Strobe captures address on the negative edge, as shown in Figure 15

SC2 is configured as Read/Write and is used to control the direction of data bus transfers. An MPU read is enabled when Read/Write and E are high

P10-P17 (PORT 1)

Port 1 is a mode independent 8-bit I/O port with each line an input or output as defined by the Port 1 Data Direction Register The TTL compatible three-state output buffers can drive one Schottky TTL load and 30 pF, Darlington transistors, or CMOS devices using external pullup resistors. It is configured as a data input port by RESET. Unused lines can remain unconnected.

P20-P24 (PORT 2)

Port 2 is a mode-independent, 5-bit, multipurpose I/O port The voltage levels present on P20, P21, and P22 on the rising edge of RESET determine the operating mode of the MCU. The entire port is then configured as a data input port. The Port 2 lines can be selectively configured as data output lines by setting the appropriate bits in the Port 2 Data Direction Register. The Port 2 Data Register is used to move data through the port. However, if P21 is configured as an output, it will be tied to the timer Output Compare function and cannot be used to provide output from the Port. 2 Data Register.

Port 2 can also be used to provide an interface for the Serial Communications Interface and the timer Input Edge function. These configurations are described in the appropriate SCI and Timer sections of this publication.

The Port 2 three-state, TTL compatible output buffers are capable of driving one Schottky TTL load and 30 pF or CMOS devices using external pullup resistors

PORT 2 DATA REGISTER

| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | |
|-----|-----|-----|-----|-----|-----|-----|-----|--------|
| PC2 | PC1 | PC0 | P24 | P23 | P22 | P21 | P20 | \$0003 |

P30-P37 (PORT 3)

Port 3 can be configured as an I/O port, a bidirectional 8-bit data bus, or a multiplexed address/data bus depending on the operating mode. The TTL compatible three-state output buffers can drive one Schottky TTL load and 90 pF Unused lines can remain unconnected.

Port 3 In Single-Chip Mode

Port 3 is an 8-bit I/O port in the Single-Chip Mode, with each line configured by the Port 3 Data Direction Register There are also two lines, $\overline{1S3}$ and $\overline{OS3}$, which can be used to control Port 3 data transfers

Three Port 3 options are controlled by the Port 3 Control and Status Register and are available only in Single-Chip Mode (1) Port 3 input data can be latched using IS3 as a control signal, (2) $\overline{OS3}$ can be generated by either an MPU read or write to the Port 3 Data Register, and (3) an $\overline{IRQ1}$ interrupt can be enabled by an $\overline{IS3}$ negative edge Port 3 latch timing is shown in Figure 6

PORT 3 CONTROL AND STATUS REGISTER

| / | 0 | 5 | 4 | 3 | 2 | 1 | U | |
|-------------|-----------------------|---|-----|-----------------|---|---|---|--------|
| IS3 Flag | IS3 IRQ1 Enable | × | oss | Latch Enable | X | X | × | \$000F |

Bit 0-2

Not used

Bit 3

LATCH ENABLE This bit controls the input latch for Port 3. If set, input data is latched by an IS3 negative edge. The latch is transparent after a read of Port 3. Data Register. LATCH ENABLE is along diving recent.

cleared during reset

Bit 4 OSS (Output Strobe Select) This bit determines whether OS3 will be generated by a read or write of the Port 3 Data Register When clear, the strobe is generated by a read, when set, it is generated by a write OSS is

IS3 IRQ1 ENABLE When set, an IRQ1 interrupt will be enabled whenever IS3 FLAG is set, when clear, the interrupt is inhibited. This bit is cleared during reset.

IS3 FLAG This read-only status bit is set by an IS3 negative edge. It is cleared by a read of the Port 3 Control and Status Register (with IS3 FLAG set) followed by a read or write to the Port 3 Data Register or during reset

Port 3 In Expanded Non-Multiplexed Mode

Port 3 is configured as a bidirectional data bus (D7-D0) in the Expanded Non-Multiplexed Mode. The direction of data transfers is controlled by Read/Write (SC2). Data is clocked by E (Enable)

Port 3 In Expanded Multiplexed Mode

Port 3 is configured as a time multiplexed address (A0-A7) and data bus (D7-D0) in the Expanded Multiplexed Modes where Address Strobe (AS) can be used to demultiplex the two buses Port 3 is held in a high impedance state between valid address and data to prevent potentional bus conflicts

Bit 7

P40-P47 (PORT 4)

Port 4 is configured as an 8-bit I/O port, as address outputs, or as data inputs depending on the operating mode Port 4 can drive one Schottky TTL load and 90 pF and is the only port with internal pullup resistors. Unused lines can remain unconnected

Port 4 In Single Chip Mode

In Single Chip Mode, Port 4 functions as an 8-bit I/O port with each line configured by the Port 4 Data Direction Register. Internal pullup resistors allow the port to directly interface with CMOS at 5 volt levels. External pullup resistors to more than 5 volts, however, cannot be used

Port 4 In Expanded Non-Multiplexed Mode

Port 4 is configured during reset as an 8-bit input port, where the Port 4 Data Direction Register can be written to provide any or all of eight address lines A0 to A7 Internal pullup resistors pull the lines high until the Port 4 Data Direction Register is configured

Port 4 In Expanded Multiplexed Mode

In all Expanded Multiplexed modes except Mode 6, Port 4 functions as half of the address bus and provides A8 to A15 In Mode 6, the port is configured during reset as an 8-bit parallel input port, where the Port 4 Data Direction Register can be written to provide any or all of upper address lines A8 to A15 Internal pullup resistors pull the lines high until the Port 4 Data Direction Register is configured, where bit 0 controls A8.

RESIDENT MEMORY

The MC68701 has 128 bytes of onboard RAM and 2048 bytes of onboard UV erasable EPROM. This memory is controlled by four bits in the RAM/EPROM Control Register.

One half of the RAM is powered through the V_{CC} standby pin and is maintainable during V_{CC} powerdown. This standby portion of the RAM consists of 64 bytes located from \$80 through \$8F.

Power must be supplied to V_{CC} standby if the internal RAM is to be used, regardless of whether standby power operation is anticipated. In Mode 3, V_{CC} standby should be tied to ground

The RAM is controlled by the RAM/EPROM Control Register

RAM/EPROM CONTROL REGISTER (\$14)

The RAM/EPROM Control Register includes four bits STBY PWR, RAME, PPC, and PLC. Two of these bits, STBY PWR and RAME, are used to control RAM access and determine the adequacy of the standby power source during power-down operation. It is intended that RAME be cleared and STBY PWR be set as part of a power-down procedure RAME and STBY PWR are Read/Write bits.

The remaining two bits, PLC and PPC, control the operation of the EPROM. PLC and PPC are readable in all modes but can be changed only in Mode 0. The PLC bit can be written without restriction in Mode 0, but operation of the PPC bit is controlled by the state of PLC

Associated with the EPROM are an 8-bit data latch and a 16-bit address latch. The data latch is enabled at all times,

latching each data byte written to the EPROM. The address latch is controlled by the PLC bit

A description of the RAM/EPROM Control Register follows

MC68701 RAM/EPROM CONTROL REGISTER

| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | |
|-------------|------|---|---|---|---|-----|-----|------|
| STBY PWR | RAME | Х | Х | Х | × | PPC | PLC | \$14 |

Bit 0

PLC Programming Latch Control This bit controls (a) a latch which captures the EPROM address to be programmed and (b) whether the PPC bit can be cleared. The latch is triggered by an MPU write to a location in the EPROM. This bit is set during reset and can be cleared only in Mode 0. The PLC bit is defined as follows.

PLC=0 EPROM address latch enabled, EPROM address is latched during MPU writes to the EPROM

PLC=1 EPROM address latch is transparent

Bit 1

PPC Programming Power Control This bit gates power from the RESET/Vpp pin to the EPROM programming circuit PPC is set during reset and whenever the PLC bit is set it can be cleared only if (a) operating in Mode 0, and (b) if PLC has been previously cleared The PPC bit is defined as follows

PPC = 0 EPROM programming power (Vpp) applied

PPC = 1 EPROM programming power (Vpp) is not applied

Bit 2-5

Bit 6 RAME

RAM Enable This Read/Write bit can be used to remove the entire RAM from the internal memory map RAME is set (enabled) during reset provided standby power is available on the positive edge of reset If RAME is clear, any access to a RAM address is external. If RAME is set and not in Mode 3, the RAM is included in the in-

ternal map

Bit 7 STBY PWR

Standby Power This bit is a Read/Write status bit which is cleared whenever V_{CC} Standby decreases below V_{SBB} (min) It can be set only by software and is not affected during reset

Note that if PPC and PLC are set, they cannot be simultaneously cleared with a single MPU write The PLC bit must be cleared prior to attempting to clear PPC. If both PPC and PLC are clear, setting PLC will also set PPC. In addition,

it is assumed that Vpp is applied to the RESET/Vpp pin whenever PPC is clear. If this is not the case, the result is undefined

ERASING THE MC68701 EPROM

Ultraviolet erasure will clear all bits of the EPROM to the "0" state. Note that this erased state differs from that of some other widely used EPROMs (such as the MCM68708) where the erased state is a "1". The MC68701 EPROM is programmed by erasing it to "0"s" and entering "1"s" into the desired bit locations.

The MC68701 EPROM can be erased by exposure to high intensity ultraviolet light with a wave length of 2537A for a minimum of 30 minutes. The recommended integrated dose (UV intensity X exposure time) is 15 Ws/cm. The lamps should be used without shortwave filters and the MC68701 should be positioned about one inch away from the UV tubes.

The MC68701 transparent lid should always be covered after erasing. This protects both the EPROM and light-sensitive nodes from accidental exposure to ultraviolet light

PROGRAMMING THE MC68701 EPROM

When the MC68701 is released from Reset in Mode 0, a vector is fetched from location \$BFFE BFFF. This provides a method for an external program to obtain control of the microcomputer with access to every location in the EPROM.

To program the EPROM, it is necessary to operate the MC68701 in Mode 0 under the control of a program resident in external memory which can facilitate loading and programming of the EPROM. After the pattern has been loaded into external memory, the EPROM can be programmed as follows.

- Apply programming power (Vpp) to the RESET/Vpp pin
- b Clear the PLC control bit and set the PPC bit by writing \$FE to the RAM/EPROM Control Register
- c Write data to the next EPROM location to be programmed Triggered by an MPU write to the EPROM, internal latches capture both the EPROM address and the data byte
- d Clear the PPC bit for programming time, tpp, by writing \$FC to the RAM/EPROM Control Register and waiting for time, tpp This step gates the programming power (Vpp) from the RESET/Vpp pin to the EPROM which programs the location
- e Repeat steps b through d for each byte to be programmed
- f Set the PLC and PPC bits by writing \$FF to the RAM/EPROM control register
- g. Remove the programming power (Vpp) from the RESET/Vpp pin The EPROM can now be read and verified

Because of the erased state of an EPROM byte is \$00, it is not necessary to program a location which is to contain \$00 Finally, it should be noted that the result of inadvertently programming a location more than once is the logical OR of the data patterns

A routine which can be used to program the MC68701 EPROM is provided at the end of this publication. This non-reentrant routine requires four double byte variables named IMBEQ, IMEND, PNTR, and WAIT to be initialized prior to entry to the routine. These variables indicate (a) the first and last memory locations which bound the data to be programmed into the EPROM, (b) the first EPROM location to be programmed, and (c) a number which is used to generate the programming time delay. The last variable, WAIT, takes into account the MCU input crystal (or TTL-compatible clock) frequency to insure the programming time, t_{pp} , is met. WAIT is defined as the number of MPU E-cycles that will occur in the real-time EPROM programming interval, t_{pp} . For example, if t_{pp} =50 milliseconds and the MC68701 is being driven with a 4.00 MHz TTL-compatible clock.

WAIT (MPU E-cycles) = $t_{pp} \cdot (MCU INPUT FREQ)/4 \cdot 10^6$ = 50000(4 \cdot 10^6)/4 \cdot 10^6 = 50000

NOTE

A monitor program called PRObug[®] is available from Motorola Microsystems PRObug contains a user option for programming the on-board MC68701 EPROM

PROGRAMMABLE TIMER

The Programmable Timer can be used to perform input waveform measurements while independently generating an output waveform Pulse widths can vary from several microseconds to many seconds A block diagram of the Timer is shown in Figure 23

COUNTER (\$09:0A)

The key timer element is a 16-bit free-running counter which is incremented by E (Enable). It is cleared during reset and is read-only with one exception, a write to the counter (\$09) will preset it to \$FFF8. This feature, intended for testing, can disturb serial operations because the counter provides the SCI internal bit rate clock. TOF is set whenever the counter contains all 1's

OUTPUT COMPARE REGISTER (\$0B:0C)

The Output Compare Register is a 16-bit Read/Write register used to control an output waveform or provide an arbitrary timeout flag. It is compared with the free-running counter on each E-cycle. When a match occurs, OCF is set and OLVL is clocked to an output level register. If Port 2, bit 1, is configured as an output, OLVL will appear at P21 and the Output Compare Register and OLVL can then be changed for the next compare. The function is inhibited for one cycle after a write to the high byte of the Compare Register (\$0B) to ensure a valid compare. The Output Compare Register is set to \$FFFF during reset.

INPUT CAPTURE REGISTER (\$0D:0E)

The Input Capture Register is a 16-bit read-only register used to store the free-running counter when a "proper" input transition occurs as defined by IEDG Port 2, bit 0 should be configured as an input, but the edge detect circuit always

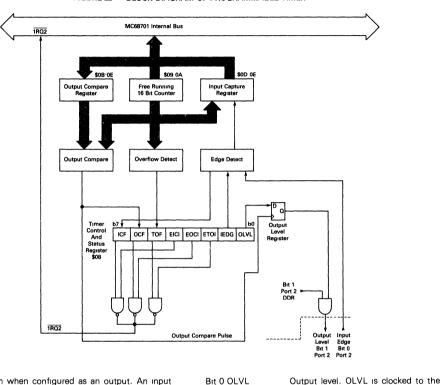


FIGURE 23 - BLOCK DIAGRAM OF PROGRAMMABLE TIMER

senses P20 even when configured as an output. An input capture can occur independently of ICF: the register always contains the most current value. Counter transfer is inhibited, however, between accesses of a double byte MPU read. The input pulse width must be at least two E-cycles to ensure an input capture under all conditions.

TIMER CONTROL AND STATUS REGISTER (\$08)

The Timer Control and Status Register (TCSR) is an 8-bit register of which all bits are readable while bits 0-4 can be written. The three most significant bits provide the timer status and indicate if:

- a proper level transition has been detected,
- a match has occurred between the free-running counter and the output compare register, and
- the free-running counter has overflowed.

Each of the three events can generate an IRQ2 interrupt and is controlled by an individual enable bit in the TCSR

TIMER CONTROL AND STATUS REGISTER (TCSR)

| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | | |
|-----|-----|-----|------|------|------|------|------|--------|--|
| ICF | OCF | TOF | EICI | EOCI | ETOI | IEDG | OLVL | \$0008 | |

Bit 0 OLVL

Bit 1 FIDG

Bit 2 ETOI

Bit 3 EOCI

Bit 4 EICI

Input Edge IEDG is cleared during reset and controls which level transition will trigger a counter transfer to the Input Capture Register

output level register by a successful output compare and will appear at P21

if Bit 1 of the Port 2 Data Direction

Register is set. It is cleared during

IEDG = 0 Transfer on a negative-edge IEDG = 1 Transfer on a positive-edge.

Enable Timer Overflow Interrupt. When set, an IRQ2 interrupt is enabled for a timer overflow; when clear, the interrupt is inhibited. It is cleared during reset

Enable Output Compare Interrupt When set, an IRQ2 interrupt is enabled for an output compare, when clear, the interrupt is inhibited. It is cleared during reset

Enable Input Capture Interrupt When set, an IRQ2 interrupt is enabled for an input capture, when clear, the interrupt is inhibited. It is cleared during reset

Bit 5 TOF Timer Overflow Flag TOF is set when

the counter contains all 1's lt is cleared by reading the TCSR (with TOF set) then reading the counter high

byte (\$09), or by RESET

Bit 6 OCF Output Compare Flag OCF is set when the Output Compare Register matches the free-running counter. It is

matches the free-running counter. It is cleared by reading the TCSR (with OCF set) and then writing to the Output Compare Register (\$0B or \$0C), or

by RESET

Bit 7 ICF Input Capture Flag ICF is set to in-

dicate a proper level transition, it is cleared by reading the TCSR (with ICF set) and then the Input Capture Register High Byte (\$0D), or by

RESET

SERIAL COMMUNICATIONS INTERFACE (SCI)

A full-duplex asynchronous Serial Communications Interface (SCI) is provided with two data formats and a variety of rates. The SCI transmitter and receiver are functionally independent, but use the same data format and bit rate. Serial data formats include standard mark/space (NRZ) and Biphase and both provide one start bit, eight data bits, and one stop bit. "Baud" and "bit rate" are used synonymously in the following description.

WAKE-UP FEATURE

In a typical serial loop multi-processor configuration, the software protocol will usually identify the addressee(s) at the beginning of the message In order to permit uninterested MPU's to ignore the remainder of the message, a wake-up feature is included whereby all further SCI receiver flag (and interrupt) processing can be inhibited until the data line goes idle. An SCI receiver is re-enabled by an idle string of ten consecutive 1's or by RESET. Software must provide for the required idle string between consecutive messages and prevent it within messages.

PROGRAMMABLE OPTIONS

The following features of the SCI are programmable

- format: standard mark/space (NRZ) or Bi-phase
- clock: external or internal bit rate clock
- Baud . one of 4 per E-clock frequency, or external clock (X8 desired baud)
- wake-up feature enabled or disabled
- Interrupt requests enabled individually for transmitter and receiver
- clock output internal bit rate clock enabled or disabled to P22

SERIAL COMMUNICATIONS REGISTERS

The Serial Communications Interface includes four addressable registers as depicted in Figure 24. It is controlled by the Rate and Mode Control Register and the

Transmit/Receive Control and Status Register Data is transmitted and received utilizing a write-only Transmit Register and a read-only Receive Register. The shift registers are not accessible to software.

Rate and Mode Control Register (RMCR) (\$10)

The Rate and Mode Control Register controls the SCI bit rate, format, clock source, and under certain conditions, the configuration of P22. The register consists of four write-only bits which are cleared by RESET. The two least significant bits control the bit rate of the internal clock and the remaining two bits control the format and clock source.

RATE AND MODE CONTROL REGISTER (RMCR)

| _ 7 | 6 | 5 | 4 | 3 | 2 | 1_ | 0 | |
|-----|---|---|---|-----|-----|-----|-----|--------|
| Х | Х | Х | Х | CC1 | CC0 | SS1 | SS0 | \$0010 |

Bit 1 Bit 0 SS1.SS0 S

SS1.SS0 Speed Select These two bits select the Baud when using the internal clock Four rates may be selected which are a function of the MCU input frequency Table 6 lists bit time and rates for three selected MCU frequencies

Bit 3.Bit 2

CC1 CC0 Clock Control and Format Select These two bits control the format and select the serial clock source If CC1 is set, the DDR value for P22 is forced to the complement of CC0 and cannot be altered until CC1 is cleared. If CC1 is cleared after having been set, its DDR value is unchanged. Table 7 defines the formats, clock source, and use of P22

If both CC1 and CC0 are set, an external TTL compatible clock must be connected to P22 at eight times (8X) the desired bit rate, but not greater than E, with a duty cycle of 50% (\pm 10%) If CC1 CC0=10, the internal bit rate clock is provided at P22 regardless of the values for TE or RE

NOTE: The source of SCI internal bit rate clock is the timer free running counter. An MPU write to the counter can disturb serial operations.

Transmit/Receive Control And Status Register (TRCSR) (\$11)

The Transmit/Receive Control and Status Register controls the transmitter, receiver, wake-up feature, and two individual interrupts and monitors the status of serial operations. All eight bits are readable while bits 0 to 4 are also writable. The register is initialized to \$20 by RESET.

TRANSMIT/RECEIVE CONTROL AND STATUS REGISTER (TRCSR)

| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | |
|------|------|------|-----|----|-----|----|----|--------|
| RDRF | ORFE | TDRE | RIE | RE | TIE | TE | WU | \$0011 |

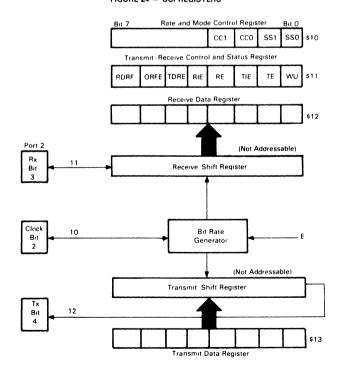
TABLE 6 - SCI BIT TIMES AND RATES

| | S1:SS0 | 4fo- | 2.4576 MHz | 4.0 MHz | 4.9152 MHz | |
|---------|----------------|--------|-------------------|---------------------|---------------------|--|
| 331.330 | | E | 614.4 kHz | 1.0 MHz | 1.2288 MHz | |
| С | 0 | - 16 | 26 μs/38,400 Baud | 16 μs/62,500 Baud | 13 0 μs/76,800 Baud | |
| C |) 1 | - 128 | 208 μs/4,800 Baud | 128 μs/7812 5 Baud | 104 2 μs/9,600 Baud | |
| 1 | 0 | - 1024 | 1 67 ms/600 Baud | 1 024 ms/976 6 Baud | 833 3 μs/1,200 Baud | |
| 1 | 1 | - 4096 | 6 67 ms/150 Baud | 4 096 ms/244 1 Baud | 3 33 ms/300 Baud | |
| Г | External (P22) | | Up to 76,800 Baud | Up to 125,000 Baud | Up to 153,600 Baud | |

TABLE 7 - SCI FORMAT AND CLOCK SOURCE CONTROL

| CC1: | CC0 | Format | Clock Source | Port 2, Bit 2 | | |
|------|-----|----------|--------------|---------------|--|--|
| 0 | 0 | Bı-Phase | Internal | Not Used | | |
| 0 | 1 | NRZ | Internal | Not Used | | |
| 1 | 0 | NRZ | Internal | Output | | |
| 1 | 1 | NRZ | External | Input | | |

FIGURE 24 - SCI REGISTERS



Bit 0 WU "Wake-up" on Idle Line When set, WU enables the wake-up function, it is cleared by ten consecutive 1's or during reset WU will not set if the line is

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Bit 1 TE Transmit Enable When set, P24 DDR

bit is set, cannot be changed, and will remain set if TE is subsequently cleared. When TE is changed from clear to set, the transmitter is connected to P24 and a preamble of nine consecutive 1's is transmitted TE is

cleared during reset

Bit 2 TIE Transmit Interrupt Enable. When set, an IRO2 interrupt is enabled when TDRE is set, when clear, the interrupt

is inhibited. TE is cleared during reset. Receive. Enable. When set, the P23 DDR bit is cleared, cannot be changed, and will remain clear if RE is subsequently cleared. While RE is set, the

SCI receiver is enabled RE is cleared

during reset

Bit 3 RE

Bit 4 RIE Receiver Interrupt Enable When set,

an IRQ2 interrupt is enabled when RDRF and/or ORFE is set, when clear, the interrupt is inhibited RIE is cleared

during reset

Bit 5 TDRE Transmit Data Register Empty. TDRE

is set when the Transmit Data Register is transferred to the output serial shift register or during reset. It is cleared by reading the TRCSR (with TDRE set) and then writing to the Transmit Data Register. Additional data will be transmitted only if TDRE has been

cleared.

Bit 6 ORFE

Overrun Framing Error. If set, ORFE indicates either an overrun or framing error. An overrun is a new byte ready to

transfer to the Receiver Data Register with RDRF still set A receiver framing error has occurred when the byte

boundaries of the bit stream are not synchronized to the bit counter. An overrun can be distinguished from a framing error by the state of RDRF, if RDRF is set, then an overrun has occurred, otherwise a framing error has been detected. Data is not transferred to the Receive Data Register in an overrun condition. Unframed data causing a framed error is transferred to the Receive Data Register However, subsequent data transfer is blocked until the framing error flag is cleared * ORFE is cleared by reading the TRCSR (with ORFE set) then the Receive Data Register, or during reset

Bit 7 RDRF

Receive Data Register Full RDRF is set when the input serial shift register is transferred to the Receive Data Register. It is cleared by reading the TRCSR (with RDRF set), and then the Receive Data Register, or during reset.

SERIAL OPERATIONS

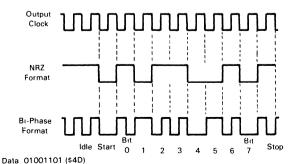
The SCI is initialized by writing control bytes first to the Rate and Mode Control Register and then to the Transmit/Receive Control and Status Register. When TE is set, the output of the transmit serial shift register is connected to P24 and serial output is initiated by transmitting to 9-bit preamble of 1's

At this point one of two situations exist. 1) if the Transmit Data Register is empty (TDRE = 1), a continuous string of 1's will be sent indicating an idle line, or 2) if a byte has been written to the Transmit-Data Register (TDRE = 0), it will be transferred to the output serial shift register (synchronized with the bit rate clock), TDRE will be set, and transmission will begin

The start bit (0), eight data bits (beginning with bit 0) and a stop bit (1), will be transmitted. If TDRE is still set when the

^{*}Devices made with mask numbers T7A and CB4 do not transfer unframed data to the Receive Data Register





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next byte transfer should occur, 1's will be sent until more data is provided. In Bi-phase format, the output toggles at the start of each bit and at half-bit time when a "1" is sent Receive operation is controlled by RE which configures P23 as an input and enables the receiver. SCI data formats are illustrated in Figure 25.

INSTRUCTION SET

The MC68701 is upward source and object code compatible with the MC6800 Execution times of key instructions have been reduced and several new instructions have been added, including a hardware multiply. A list of new operations added to the MC6800 instruction set is shown in Table 1

The coding of the first (or only) byte corresponding to an executable instruction is sufficient to identify the instruction and the addressing mode. The hexadecimal equivalents of the binary codes, which result from the translation of the 82 instructions in all valid modes of addressing, are shown in Table 8. There are 220 valid machine codes, 34 unassigned codes, and 2 reserved for test purposes.

PROGRAMMING MODEL

A programming model for the MC68701 is shown in Figure 11 Accumulator A can be concatenated with accumulator B and jointly referred to as accumulator D where A is the most significant byte. Any operation which modifies the double accumulator will also modify accumulator A and/or B. Other registers are defined as follows:

Program Counter — The program counter is a 16-bit register which always points to the next instruction.

Stack Pointer — The stack pointer is a 16-bit register which contains the address of the next available location in a pushdown/pullup (LIFO) queue. The stack resides in random access memory at a location defined by the programmer.

Index Register — The Index Register is a 16-bit register which can be used to store data or provide an address for the indexed mode of addressing

Accumulators — The MCU contains two 8-bit accumulators, A and B, which are used to store operands and results from the arithmetic logic unit (ALU) They can also be concatenated and referred to as the D (double) accumulator.

Condition Code Registers — The condition code register indicates the results of an instruction and includes the

following five condition bits: Negative (N), Zero (Z), Overflow (V), Carry/Borrow from MSB (C), and Half Carry from bit 3 (H). These bits are testable by the conditional branch instructions Bit 4 is the interrupt mask (I-bit) and inhibits all maskable interrupts when set. The two unused bits, b6 and b7 are read as ones.

ADDRESSING MODES

The MC68701 provides six addressing modes which can be used to reference memory. A summary of addressing modes for all instructions is presented in Tables 9, 10, 11, and 12 where execution times are provided in E-cycles. Instruction execution times are summarized in Table 13. With an input frequency of 4 MHz, E-cycles are equivalent to microseconds. A cycle-by-cycle description of bus activity for each instruction is provided in Table 14 and a description of selected instructions is shown in Figure 26.

Immediate Addressing — The operand or "immediate byte(s)" is contained in the following byte(s) of the instruction where the number of bytes matches the size of the register. These are two or three byte instructions.

Direct Addressing — The least significant byte of the operand address is contained in the second byte of the instruction and the most significant byte is assumed to be \$00 Direct addressing allows the user to access \$00 through \$FF using two byte instructions and execution time is reduced by eliminating the additional memory access. In most applications, the 256-byte area is reserved for frequently referenced data

Extended Addressing — The second and third bytes of the instruction contain the absolute address of the operand These are three byte instructions

Indexed Addressing — The unsigned offset contained in the second byte of the instruction is added with carry to the Index Register and used to reference memory without changing the Index Register. These are two byte instructions

Inherent Addressing — The operand(s) are registers and no memory reference is required. These are single byte instructions.

Relative Addressing — Relative addressing is used only for branch instructions. If the branch condition is true, the Program Counter is overwritten with the sum of a signed single byte displacement in the second byte of the instruction and the current Program Counter. This provides a branch range of -126 to 129 bytes from the first byte of the instruction. These are two byte instructions.

DES TXS PSHA PSHB PULX RTS ABX RTI MODE MODE MNEM MODE OP MNEM MODE ASL ROL DEC 34 35 36 37 38 39 34 30 31 40 42 43 44 45 46 47 48 49 44 45 45 45 51 9C 9D 9E 9F 40 A1 A2 A3 A4 A5 A6 A7 A8 A9 AA AB AC AD B1 B2 NOF JSR LDS STS SUBA CMPA SBCA SUBD ANDA BITA LDAA STAA EORA ADCA ORAA ADDA CMPB SBCB ADDD ANDB BITB LDAB STAB EORB ADCB ORAB ADDB LDD STD LDX STX SUBB CMPB SBCB ADDD ANDB INC TST JMP CLR NEG LSRD INDXD ASLD TAP TPA INX DEX CLV SEV CLC SEC CLI SEI SBA CBA 5 3 10 4 10 9 INDXD EXTND PSHX MUL WAI SWI NEGA COM ROR ASR ASL ROL DEC COMA CPX JSR LDS STS SUBA CMPA SBCA RORA ASRA ASLA ROLA INDXD EXTND INC TST JMP CLR SUBA CMPA SBCA SUBD ANDA BITA LDAA BITB LDAB STAB EORB ADCB ORAB ADDB TAB TBA DECA EXTND IMMED SUBD ANDA BITA LDAA STAA EORA ADCA ORAA ADDA CPX JSR LDS STS SUBB CMPB INCA TSTA DAA CLRA NEGB ABA LDD STD LDX STX SUBB CMPB SBCB ADDD COME INDXD EXTND EORA ADCA ORAA ADDA CPX BRA BRN BHI BLS BCC BCS BNE BEQ BVC BVS BPL BMI BGE TSS INS PULB RORB ASRB ADDD ANDB BITB LDAB STAB EORB ADCB ORAB ROLB DECB BSR REL IMMED SBCB ADDD ANDB BITB SUBA CMPA SBCA SUBD INCB TSTB LDAB ADDB LDD STD CLRB C7 C8 C9 CA CB CC CD ANDA BITA LDAA STAA EORA ADCA ORAA EORB NEG ADCE ORAB ADDB LDD LDX EXTND. COM LSR IMMED UNDEFINED OF GODE LDX ROR

TABLE 8 — CPU INSTRUCTION MAP

NOTES:

- 1. Addressing Modes
 - INHER ≡ Inherent
 - REL ≡ Relative
 - INDXD ≡ Indexed
 - EXTND = Extended
 - IMMED ≡ Immediate
 - Dir≡ Direct
- 2. Unassigned op codes indicated by "*" and should not be executed.
- 3. Codes marked by "T" force the PC to function as a 16-bit counter.

TABLE 9 - INDEX REGISTER AND STACK MANIPULATION INSTRUCTIONS

| | | | | | | | | | | | | | | | | | | T | Con | diti | on I | Cod | es |
|------------------------|----------|----|----|----|----|-----|----|----|-----|---|----|-----|----|-----|-----|-----|--|----------|-----|------|------|-----|------------|
| | } | In | nm | ed | D | ire | ct | Ir | nde | X | E | xtr | ıd | Int | ner | ent | t | 5 | 4 | 3 | 2 | 1 | To |
| Pointer Operations | Mnemonic | OP | ~ | # | OP | ~ | # | OP | ` | # | OP | ~ | # | OP | ~ | # | Boolean / | Н | T | N | Z | V | С |
| | | | | L | | | Ш | | | L | | | | | L | L | Arithmetic Operation | 1- | L | L | L | | |
| Compare Index Reg | CPX | 8C | 4 | 3 | 9C | 5 | 2 | AC | 6 | 2 | вс | 6 | 3 | | L | L. | X - M M + 1 | • | • | 1 | I | 1 | 1 |
| Decrement Index Reg | DEX | | | | | | П | | | | | Γ | | 09 | 3 | 1 | X - 1X | • | • | • | 1 | | • |
| Decrement Stack Pntr | DES | | | | | | П | | | | | Γ | | 34 | 3 | 1 | SP - 1 - SP | • | • | • | • | • | • |
| Increment Index Reg | INX | | | | | | | | | | | | | 08 | 3 | 1 | X + 1X | • | • | • | T | • | • |
| Increment Stack Pntr | INS | | | | | | | | | | | | | 31 | 3 | 1 | 1 SP + 1 SP | • | • | • | • | • | • |
| Load Index Reg | LDX | CE | 3 | 3 | DE | 4 | 2 | EE | 5 | 2 | FE | 5 | 3 | | | | MXH, (M + 1)XL | • | • | T | 1 | R | • |
| Load Stack Pntr | LDS | 8E | 3 | 3 | 9E | 4 | 2 | ΑE | 5 | 2 | BE | 5 | 3 | | | | M SPH, (M + 1) SPL | • | • | 1 | 1 | R | • |
| Store Index Reg | STX | | Г | | DF | 4 | 2 | EF | 5 | 2 | FF | 5 | 3 | | | | X _H -M, X _L -(M + 1) | • | • | 1 | 11 | R | • |
| Store Stack Pntr | STS | | | | 9F | 4 | 2 | ΑF | 5 | 2 | BF | 5 | 3 | | | | SPH -M, SPL -(M + 1) | • | • | П | 11 | R | • |
| Index Reg - Stack Pntr | TXS | | | | | | П | | | | | Γ | | 35 | 3 | 1 | X - 1 SP | • | • | • | | • | • |
| Stack Pntr → Index Reg | TSX | | | | | | П | | | | | Г | | 30 | 3 | 1 | SP + 1X | • | • | • | | • | • |
| Add | ABX | | | | | | П | | | | | Г | | 3A | 3 | 1 | B + XX | | • | | • | • | • |
| Push Data | PSHX | | | | | | П | | | | | Γ | | 3C | 4 | 1 | XL -MSP, SP - 1 -SP | • | • | • | • | • | • |
| | | | | | | | Ш | | | | L | L | | | | | XH -MSP SP - 1 -SP | <u> </u> | | L | L | | <u>L</u> _ |
| Pull Data | PULX | | | | | | П | | | | | | | 38 | 5 | 1 | SP + 1 -SP, MSP -XH | • | • | • | | • | • |
| | 1 | | | | | | | | | | | l | | | | 1 | SP + 1 -SP, MSP -XL | 1 | ł | 1 | 1 | | 1 |

TABLE 10 - ACCUMULATOR AND MEMORY INSTRUCTIONS

| Accumulator and | 1 | Ir | nme | be | | ire | ct | ı | nde | x | E | xte | nd | Ī | nhe | r | Boolean | (| on | dite | on | Cc | ode | s |
|-------------------|------|----|-----|----|----|-----|----|----|-----|---|----|---------------|----|----|-----|---|--------------------|-------|----|------|----|----|-----|---|
| Memory Operations | MNE | Op | ~ | # | Op | ~ | # | Op | ~ | # | Op | ~ | # | Op | ~ | # | Expression | Н | Π | IN | T | zΤ | V | c |
| Add Acmitrs | ABA | | Г | Г | | | П | | | | | Г | | 1B | 2 | 1 | A + B A | IT | • | 1 | 17 | П | T | T |
| Add B to X | ABX | | | Г | | | П | | | Т | | | | 3A | 3 | 1 | 00 B + X - X | • | • | • | | | • | • |
| Add with Carry | ADCA | 89 | 2 | 2 | 99 | 3 | 2 | Α9 | 4 | 2 | В9 | 4 | 3 | | | | A + M + C - A | T | • | 1 | 77 | 丌 | T | T |
| | ADCB | C9 | 2 | 2 | D9 | 3 | 2 | E9 | 4 | 2 | F9 | 4 | 3 | | | | B + M + C - B | | • | Ħ | T | π | T | T |
| Add | ADDA | 8B | 2 | 2 | 9B | 3 | 2 | AB | 4 | 2 | BB | 4 | 3 | | | | A + M A | | • | T | 17 | П | T | T |
| | ADDB | СВ | 2 | 2 | DB | 3 | 2 | EΒ | 4 | 2 | FB | 4 | 3 | | | Г | B + M A | Π | • | Ħ | 17 | π | 1 | T |
| Add Double | ADDD | С3 | 4 | 3 | D3 | 5 | 2 | E3 | 6 | 2 | F3 | 6 | 3 | | | Г | D + M M + 1 - D | • | • | Ħ | 17 | П | Ħ | T |
| And | ANDA | 84 | 2 | 2 | 94 | 3 | 2 | A4 | 4 | 2 | B4 | 4 | 3 | | | Г | A·M A | • | • | Ħ | | IT | R | • |
| | ANDB | C4 | 2 | 2 | D4 | 3 | 2 | E4 | 4 | 2 | F4 | 4 | 3 | | | | B · M → B | • | • | 1 | T | π | R | • |
| Shift Left, | ASL | | | | | | | 68 | 6 | 2 | 78 | 6 | 3 | | | Г | | • | • | 11 | | П | T | T |
| Arithmetic | ASLA | | | | | | | | | | | | | 48 | 2 | 1 | C- <u> </u> | • | • | 1 | 17 | П | T | + |
| | ASLB | | | | | | | | | | | $\overline{}$ | _ | 58 | 2 | 1 | b7 b0 | • | • | 17 | T | П | 11 | + |

TABLE 10 - ACCUMULATOR AND MEMORY INSTRUCTION (CONTINUED)

| Accumulator and Memory Operations Shift Left Dbl | | 1 - | | | - | | | - | - | . 1 | - | • | - | - | | | D | _ | | | ::- | | | |
|--|--|--|----------------|-------------|--|---------------|---|--|-----------------------|-----------------|--|---|---------------------|--|---|---|--|---|---|---|-----|---------------|---|----|
| | MNE | Op | nme | | Op | rec ~ | | Op | nd ex | | Op | ten ~ | d # | Op | her ~ | # | Boolean Expression | 片 | one | | io: | Z | ode V | C |
| June Lett DDI | ASLD | - | - | Н | - | \neg | - | - | | | - | - | " | 05 | 3 | 1 | Expression | | ÷ | ۲ | 1 | 7 | Ť | 1 |
| Shift Right, | ASR | | _ | | - | | | 67 | 6 | 2 | 77 | 6 | 3 | | _ | H | | • | • | | Н | + | \vdash | + |
| Arithmetic | ASRA | _ | _ | | | | | | | | | | | 47 | 2 | 1 | | • | • | | it | Ť | H | |
| | ASRB | | | П | | | | | | Н | | | | 57 | 2 | 1 | b7 b0 | • | • | t | H | + | 1 | 1 |
| Bit Test | BITA | 85 | 2 | 2 | 95 | 3 | 2 | Α5 | 4 | 2 | B5 | 4 | 3 | | - | | A · M | • | • | | 1 | $\dot{\tau}$ | R | |
| | BITB | C5 | 2 | 2 | D5 | 3 | 2 | E5 | 4 | 2 | F5 | 4 | 3 | | | | вм | • | • | H | 1 | 1 | R | 1 |
| Compare Acmitrs | CBA | 1 | _ | | | | | | | Н | | _ | Ť | 11 | 2 | 1 | A - B | • | • | | 1 | + | 1 | 1 |
| Clear | CLR | _ | - | | | | | 6F | 6 | 2 | 7F | 6 | 3 | | _ | H | 00 - M | • | • | | 1 | s | R | H |
| | CLRA | _ | _ | | | | | | | \vdash | | | | 4F | 2 | 1 | 00 - A | • | • | | 1 | s | R | |
| | CLRB | | _ | \vdash | | | | | - | Н | | _ | \vdash | 5F | 2 | | 00 - B | • | • | F | | s | R | |
| Compare | CMPA | 81 | 2 | 2 | 91 | 3 | 2 | Ã1 | 4 | 2 | B1 | 4 | 3 | - | - | H | A - M | • | • | t | - | Ť | 1 | 17 |
| | СМРВ | C1 | 2 | 2 | D1 | 3 | 2 | E1 | 4 | 2 | F1 | 4 | 3 | | | Н | B - M | • | • | Н | H | + | H | +1 |
| 1's Complement | COM | - | - - | - | | Ť | | 63 | 6 | 2 | 73 | 6 | 3 | | | Н | M - M | • | • | | H | + | R | s |
| , a complainem | COMA | \vdash | \vdash | | | - | \vdash | - | Ť | H | | Ť | Ť | 43 | 2 | 1 | A - A | • | • | Н | H | + | R | İs |
| | COMB | \vdash | ╁ | Н | | | \vdash | | | Н | | - | _ | 53 | 2 | | B → B | • | • | ۲ | H | + | R | |
| Decimal Adj, A | DAA | | ├- | \vdash | | - | Н | | \vdash | Н | - | - | Н | 19 | 2 | | Adj binary sum to BCD | _ | • | Н | H | + | F | 13 |
| | DEC | ├ | | \vdash | | | Н | 6A | - | 1 | 70 | - | 3 | 19 | | | | • | - | Н | + | + | Н | Ηį |
| Decrement | | ├ | - | \vdash | | - | Н | 0A | 6 | 2 | 7A | 6 | 3 | 4.0 | 2 | H | M - 1 M | - | - | Н | H | + | 1 | - |
| | DECA | ├ | - | Н | | | Н | | - | - | - | - | \vdash | 4A | 2 | | A - 1 - A | • | • | 1 | Н | + | H | |
| F -1 OD | DECB | 100 | - | <u> </u> | 00 | <u>_</u> | Ļ | 40 | - | _ | 100 | ب | ايرا | 5A | 2 | Щ | B · 1 -B | • | • | H | H | Ļ | 止 | |
| Exclusive OR | EORA | 88 | 2 | | 98 | 3 | 2 | A8 | 4 | 2 | B8 | 4 | 3 | | | Ц | A ⊕ M ←A | • | • | H | H | Ļ | R | + |
| | EORB | C8 | 2 | 2 | D8 | 3 | 2 | E8 | 4 | 2 | F8 | 4 | 3 | | | Ц | B ⊕ M → B | • | | H | 11 | 1 | R | |
| Increment | INC | | | | | <u> </u> | Ш | 6C | 6 | 2 | 7C | 6 | 3 | | _ | H | M + 1 - M | • | • | L | Н | Ļ | \vdash | |
| | INCA | <u> </u> | <u> </u> | Ш | | L. | Ш | | _ | | | | Ш | 4C | 2 | | A + 1 A | • | • | Ш | Ц | 1 | H | |
| | INCB | | L | | | | | | | | | | | 5C | 2 | 1 | B + 1 → B | • | • | Ľ | Ш | 1 | Ш | • |
| Load Acmitrs | LDAA | 86 | 2 | 2 | 96 | 3 | 2 | Α6 | 4 | 2 | В6 | 4 | 3 | | | | M -A | • | | L | Ш | 1 | R | |
| | LDAB | C6 | 2 | 2 | D6 | 3 | 2 | E6 | 4 | 2 | F6 | 4 | 3 | | | | M → B | | • | | 1 | | R | |
| Load Double | LDD | CC | 3 | 3 | DC | 4 | 2 | EC | 5 | 2 | FC | 5 | 3 | | | | M M + 1 D | • | • | | H | T | R | |
| Logical Shift, | LSL | | | | | | | 68 | 6 | 2 | 78 | 6 | 3 | | | | | • | | | 1 | 1 | | 1 |
| Left | LSLA | | | | | | | | | | | | | 48 | 2 | 1 | | • | • | | IT | T | 1 | 11 |
| | LSLB | | | | | | | | | | | | | 58 | 2 | 1 | | • | • | | H | T | T | |
| | LSLD | | | | | | | | | | | | | 05 | 3 | 1 | b7 b0 | • | • | | H | + | | 11 |
| Shift Right, | LSR | | | | | | | 64 | 6 | 2 | 74 | 6 | 3 | | | | | • | • | F | à l | + | 1 | 11 |
| Logical | LSRA | | _ | | | - | | | | | | | | 44 | 2 | 1 | 0-4111111-0 | • | • | F | | Ť | H | 11 |
| | LSRB | _ | | | | | | | | | | | | 54 | 2 | 1 | b7 b0 | • | • | F | | ÷ | 1 | +; |
| | LSRD | ├─ | - | Н | | _ | \vdash | | | - | \vdash | | | 04 | 3 | 1 | - 00 | • | • | F | | + | 11 | +; |
| Multiply | MUL | ├ | \vdash | Н | | - | \vdash | | - | - | \vdash | | Н | | 10 | 1 | A X B - D | • | • | + | • | + | • | 10 |
| 2's Complement | NEG | ├ | - | Н | | - | Н | 60 | 6 | 2 | 70 | 6 | 3 | - | | H | 00 · M → M | • | • | ۲ | 1 | Ť | Ť | Ŧ١ |
| | NEGA | ┼── | - | 1 | | - | | -00 | - | - | 1,0 | | ۲ | 40 | 2 | 1 | 00 - A - A | • | • | Н | Н | + | ۲÷ | + |
| (Negate) | | ├ | - | Н | | - | \dashv | | - | H | | - | - | 50 | | | | • | | + | H | _ | + | + |
| | NEGB | ├ | - | \dashv | | - | \vdash | - | - | Н | \vdash | _ | - | | 2 | | 00 · B - B | | • | H | 4 | ㅗ | Ť | +- |
| No Operation | NOP | - | | | | _ | | AA | | | | | _ | 01 | 2 | -4 | PC + 1 - PC | • | • | Ľ | • | • | • | 1. |
| Inclusive OR | ORAA | BA | 2 | | 9A | 3 | 2 | | 4 | 2 | BA | 4 | 3 | | | | | | | | ŧ I | | | |
| | | | | | | | | | - | | | - | | | | Н | A + M A | • | • | H | ₩ | - | R | +- |
| | ORAB | CA | | | DA | 3 | | EΑ | 4 | | FA | 4 | 3 | | _ | | B + M B | • | • | | Ц | Ī | R | • |
| Push Data | PSHA | CA | | | | | | | 4 | | | 4 | | 36 | 3 | 1 | B + M -B A -Stack | • | • | | | • | R | • |
| | PSHA PSHB | CA | | | | | | | 4 | | | 4 | | 37 | 3 | 1 | B + M -B A -Stack B - Stack | • | • | • | • | • | R • | • |
| Push Data | PSHA PSHB PULA | CA | | | | | | | 4 | | | 4 | | 37 32 | 3 | 1 | B + M -B A -Stack B - Stack Stack - A | • | • | • | • | • | R • • | • |
| Pull Data | PSHA PSHB PULA PULB | CA | | | | | | EA | | 2 | FA | | 3 | 37 | 3 | 1 | B + M -B A -Stack B - Stack | | 0 0 0 | • | • | • | R • | • |
| | PSHA PSHB PULA PULB ROL | CA | | | | | | | 6 | | | 6 | | 37 32 33 | 3 4 4 | 1 1 | B + M + B A - Stack B - Stack Stack - A Stack - B | • | • • • • • • • | | 9 | • | R • • | • |
| Pull Data | PSHA PSHB PULA PULB ROL ROLA | CA | | | | | | EA | | 2 | FA | | 3 | 37 32 | 3 4 4 | 1 | B + M -B A -Stack B - Stack Stack - A | | 0 0 0 | | • | • | R • • | • |
| Pull Data | PSHA PSHB PULA PULB ROL | CA | | | | | | EA | | 2 | FA | | 3 | 37 32 33 | 3 4 4 | 1 1 | B + M + B A - Stack B - Stack Stack - A Stack - B | | • • • • • • • | | 9 | • | R • • | |
| Pull Data Rotate Left | PSHA PSHB PULA PULB ROL ROLA | CA | | | | | | EA | | 2 | FA | | 3 | 37 32 33 49 | 3 4 4 | 1 1 1 | B + M + B A + Stack B + Stack Stack + A Stack + B | 000000 | | | 0 | • | R • • | |
| Pull Data Rotate Left | PSHA PSHB PULA PULB ROL ROLA ROLB | CA | | | | | | 69 | 6 | 2 | 79 | 6 | 3 | 37 32 33 49 | 3 4 4 | 1 1 1 | B + M + B A - Stack B - Stack Stack - A Stack - B C | | • • • • • • • • • • | | | • | R • • | |
| Pull Data | PSHA PSHB PULA PULB ROL ROLA ROLB | CA | | | | | | 69 | 6 | 2 | 79 | 6 | 3 | 37 32 33 49 59 | 3 4 4 2 2 | 1 1 1 1 | B + M + B A - Stack B - Stack Stack - A Stack - B | | • • • • • • • | | | • | R • • | |
| Pull Data Rotate Left Rotate Right | PSHA PSHB PULA PULB ROL ROLA ROLB ROR RORA RORB | CA | | | | | | 69 | 6 | 2 | 79 | 6 | 3 | 37 32 33 49 59 46 56 | 3 4 4 2 2 2 2 | 1 1 1 1 1 | B + M + B A + Stack B + Stack Stack + A Stack + B C + D + C b7 | 0 0 0 0 0 0 0 | 000000000 | | | • | R • • | |
| Pull Data Rotate Left Rotate Right Subtract Acmitr | PSHA PSHB PULA PULB ROL ROLA ROLB ROR RORA RORB SBA | | 2 | 2 | DA | 3 | 2 | 69 66 | 6 | 2 | 79 76 | 6 | 3 | 37 32 33 49 59 | 3 4 4 2 2 2 | 1 1 1 1 1 1 | B + M + B A + Stack B + Stack Stack + A Stack + B C + | 0 0 0 0 0 0 0 0 0 | 0000000000 | | | • | R • • | |
| Pull Data Rotate Left Rotate Right Subtract Acmitr Subtract with | PSHA PSHB PULA PULB ROL ROLA ROLB ROR RORA RORB SBA SBCA | 82 | 2 | 2 | DA 92 | 3 | 2 | 69 66 | 6 | 2 2 | 79 76 | 6 | 3 3 | 37 32 33 49 59 46 56 | 3 4 4 2 2 2 2 | 1 1 1 1 1 | B + M + B A - Stack B + Stack Stack + A Stack + B C + D + D + C b7 b7 b0 C + D + C A + B + A A - M - C + A | 0 0 0 0 0 0 0 0 | 0 | | | • | R • • | |
| Pull Data Rotate Left Rotate Right Subtract Acmitr Subtract with Carry | PSHA PSHB PULA PULB ROL ROLA ROLB ROR RORA RORB SBA SBCA SBCA | | 2 | 2 | DA 92 D2 | 3 3 3 | 2 2 2 | 69 66 A2 E2 | 6 6 4 4 | 2 2 2 2 | 79 76 B2 F2 | 6 6 4 4 | 3 3 3 | 37 32 33 49 59 46 56 | 3 4 4 2 2 2 2 | 1 1 1 1 1 | B + M + B A + Stack B + Stack Stack + A Stack + B C + D + C D7 D0 C D7 D0 A - B + A A - M - C - A B - M - C + B | 0 0 0 0 0 0 0 0 0 0 0 0 | 0 0 0 0 0 0 0 0 0 0 | | | • | R • • • • • • • • • • • • • • • • • • • | |
| Pull Data Rotate Left Rotate Right Subtract Acmitr Subtract with | PSHA PSHB PULA PULB ROL ROLA ROLB RORB RORA RORB SBA SBCA SBCB STAA | 82 | 2 | 2 | DA 92 D2 97 | 3 3 3 | 2 2 2 2 | 69 66 A2 E2 A7 | 6 6 4 4 4 4 | 2 2 2 2 2 | 79 76 82 F2 B7 | 6 6 4 4 4 | 3 3 3 3 | 37 32 33 49 59 46 56 | 3 4 4 2 2 2 2 | 1 1 1 1 1 | B + M → B A → Stack B → Stack Stack → A Stack → B C → □ □ □ □ □ □ □ D → □ □ D → □ □ □ D → □ □ □ D → □ □ □ D → □ D → D → □ D → D → □ D → □ D → □ D → □ D → □ D → □ D → □ D → □ D → □ D → □ D → D → □ D → □ D → □ D → □ D → □ D → □ D → □ D → □ D → □ D → □ D → D → □ D → □ D → D → D → D → D → D → D → D → D → D → | 0 | 0 | | | • | R | |
| Pull Data Rotate Left Rotate Right Subtract Acmitr Subtract with Carry | PSHA PSHB PULA PULB ROL ROLA ROLB RORB SBA SBCA SBCB STAA STAB | 82 | 2 | 2 2 2 | DA | 3 3 3 3 3 | 2 2 2 2 2 2 | 69 66 A2 E2 A7 E7 | 6 6 4 4 4 4 4 | 2 2 2 2 2 | 79 76 82 F2 B7 F7 | 6 4 4 4 4 4 | 3 3 3 3 3 | 37 32 33 49 59 46 56 | 3 4 4 2 2 2 2 | 1 1 1 1 1 | B + M + B A + Stack B + Stack Stack + A Stack + B C + | • • • • • • • • • • • • | 000000000000000000000000000000000000000 | | | • | RRR | |
| Pull Data Rotate Left Rotate Right Subtract Acmitr Subtract with Carry Store Acmitrs | PSHA PSHB PULA PULB ROLA ROLB RORA RORB SBA SBCA SBCA STAA STAB | 82 C2 | 2 2 2 | 2 2 2 | 92 D2 97 D7 DD | 3 3 3 3 4 | 2 2 2 2 2 2 2 | 69 66 A2 E2 A7 E7 ED | 6 6 4 4 4 4 5 | 2 2 2 2 2 2 | 79 76 82 F2 B7 F7 FD | 6 6 4 4 4 4 5 | 3 3 3 3 3 3 3 | 37 32 33 49 59 46 56 | 3 4 4 2 2 2 2 | 1 1 1 1 1 | B + M + B A + Stack B + Stack Stack + A Stack + B C + + + + + + + + + + + + + + + + + + | | | | | 0 0 | RRRR | |
| Pull Data Rotate Left Rotate Right Subtract Acmitr Subtract with Carry Store Acmitrs | PSHA PSHB PULA PULB ROL ROLA ROLB ROR RORA SBCA SBCA SBCA STAA STAA STD SUBA | 82 C2 | 2 2 2 | 2 2 2 2 | 92 D2 97 D7 DD 90 | 3 3 3 3 4 3 | 2 2 2 2 2 2 2 2 | 69 66 A2 E2 A7 E7 ED | 6 6 4 4 4 5 4 | 2 2 2 2 2 2 2 2 | 79 76 82 87 77 FD BO | 6 6 4 4 4 5 4 | 3 3 3 3 3 3 3 3 | 37 32 33 49 59 46 56 | 3 4 4 2 2 2 2 | 1 1 1 1 1 | B + M → B A → Stack B → Stack Stack → A Stack → B C → □ □ □ □ □ □ D → □ □ □ D → □ □ □ D → □ □ □ D → □ □ □ D → □ □ □ D → □ □ □ D → □ □ □ □ D → □ □ □ □ D → □ □ □ □ D → □ □ □ □ □ D → □ □ □ □ □ □ □ D → □ □ □ □ □ □ □ □ □ □ □ □ D → □ □ □ □ □ □ □ □ □ □ □ □ □ □ □ □ □ □ | | | | | • | RRR | |
| Pull Data Rotate Left Rotate Right Subtract Acmitr Subtract with Carry Store Acmitrs | PSHA PSHB PULA PULB ROL ROLB ROR RORB SBCA SBCA SBCB STAA STAB STD SUBA SUBB | 80 CO | 2 2 2 2 2 | 2 2 2 2 2 2 | 92 D2 97 D7 DD 90 D0 | 3 3 3 3 4 3 3 | 2 | 69 66 A2 E2 A7 E7 ED A0 E0 | 6 4 4 4 4 5 4 4 4 | 2 2 2 2 2 2 2 2 | 79 76 82 F2 B7 F7 FD B0 F0 | 6 4 4 4 4 4 4 4 4 4 4 4 4 4 4 4 4 4 4 4 | 3 3 3 3 3 3 3 3 3 3 | 37 32 33 49 59 46 56 | 3 4 4 2 2 2 2 | 1 1 1 1 1 | B + M + B A + Stack B + Stack Stack + A Stack + B C → D ← C b7 → D C b7 → D C A · B + A A · M · C + A B + M C + B A + M D + | | | | | • | R R R R | |
| Pull Data Rotate Left Rotate Right Subtract Acmitr Subtract with Carry Store Acmitrs Subtract Subtract Double | PSHA PSHB PULB ROL ROLA ROLB RORA RORB SBA SBCB STAA STAB STD SUBB SUBD | 82 C2 | 2 2 2 | 2 2 2 2 2 2 | 92 D2 97 D7 DD 90 | 3 3 3 3 4 3 | 2 | 69 66 A2 E2 A7 E7 ED | 6 6 4 4 4 5 4 | 2 2 2 2 2 2 2 2 | 79 76 82 87 77 FD BO | 6 6 4 4 4 5 4 | 3 3 3 3 3 3 3 3 | 37 32 33 49 59 46 56 10 | 2 2 2 2 | 1 1 1 1 1 1 1 | B + M + B A + Stack B + Stack Stack + A Stack + B C + M + C b7 b7 b0 C + M + C b7 C + M + C B + M C + B C + M + C B + M C + B C + M + C B + M C + B C + M + C B + M D + M M + 1 A - M + A B + M D + M M + 1 D + M M + 1 D - M M + 1 + D | | | | | 0 0 | R R R | |
| Pull Data Rotate Left Rotate Right Subtract Acmitr Subtract with Carry Store Acmitrs Subtract Subtract Double | PSHA PSHB PULA ROLA ROLB RORA RORB SBA SBCA SBCA STAB STAB STD SUBA SUBD TAB | 80 CO | 2 2 2 2 2 | 2 2 2 2 2 2 | 92 D2 97 D7 DD 90 D0 | 3 3 3 3 4 3 3 | 2 | 69 66 A2 E2 A7 E7 ED A0 E0 | 6 4 4 4 4 5 4 4 4 | 2 2 2 2 2 2 2 2 | 79 76 82 F2 B7 F7 FD B0 F0 | 6 4 4 4 4 4 4 4 4 4 4 4 4 4 4 4 4 4 4 4 | 3 3 3 3 3 3 3 3 3 3 | 37 32 33 49 59 46 56 10 | 2 | 1 | B + M → B A → Stack B → Stack Stack → A Stack → B C → → → ← C b7 → b0 C → → ← C b7 → b0 A ⋅ B → A A ⋅ M ⋅ C → A B ⋅ M ⋅ C → B A ← M B → M D → M M + 1 A ⋅ M → A B ⋅ M → B D ⋅ M M + 1 → D A → B A → B D ⋅ M M + 1 → D A → B | | | | | • | R R R R R R R R | |
| Pull Data Rotate Left Rotate Right Subtract Acmitr Subtract with Carry Store Acmitrs Subtract Subtract Double | PSHA PSHB PULB ROL ROLA ROLB RORA RORB SBA SBCB STAA STAB STD SUBB SUBD | 80 CO | 2 2 2 2 2 | 2 2 2 2 2 2 | 92 D2 97 D7 DD 90 D0 | 3 3 3 3 4 3 3 | 2 | 69 66 A2 E2 A7 E7 ED A0 E0 | 6 4 4 4 4 5 4 4 4 | 2 2 2 2 2 2 2 2 | 79 76 82 F2 B7 F7 FD B0 F0 | 6 4 4 4 4 4 4 4 4 4 4 4 4 4 4 4 4 4 4 4 | 3 3 3 3 3 3 3 3 3 3 | 37 32 33 49 59 46 56 10 | 2 2 2 2 | 1 | B + M + B A + Stack B + Stack Stack + A Stack + B C + M + C b7 b7 b0 C + M + C b7 C + M + C B + M C + B C + M + C B + M C + B C + M + C B + M C + B C + M + C B + M D + M M + 1 A - M + A B + M D + M M + 1 D + M M + 1 D - M M + 1 + D | | | | | • | R R R R R | |
| Pull Data Rotate Left Rotate Right Subtract Acmitr Subtract with Carry Store Acmitrs Subtract Subtra | PSHA PSHB PULA ROLA ROLB RORA RORB SBA SBCA SBCA STAB STAB STD SUBA SUBD TAB | 80 CO | 2 2 2 2 2 | 2 2 2 2 2 2 | 92 D2 97 D7 DD 90 D0 | 3 3 3 3 4 3 3 | 2 | 69 66 A2 E2 A7 E7 ED A0 E0 | 6 4 4 4 4 5 4 4 4 | 2 2 2 2 2 2 2 2 | 79 76 82 F2 B7 F7 FD B0 F0 | 6 6 4 4 4 5 4 4 6 | 3 3 3 3 3 3 3 3 3 3 | 37 32 33 49 59 46 56 10 | 2 | 1 | B + M → B A → Stack B → Stack Stack → A Stack → B C → → → ← C b7 → b0 C → → ← C b7 → b0 A ⋅ B → A A ⋅ M ⋅ C → A B ⋅ M ⋅ C → B A ← M B → M D → M M + 1 A ⋅ M → A B ⋅ M → B D ⋅ M M + 1 → D A → B A → B D ⋅ M M + 1 → D A → B | | | | | • | R R R R R R R R | |
| Pull Data Rotate Left Rotate Right Subtract Acmitr Subtract with Carry Store Acmitrs Subtract Subtract Double Transfer Acmitr Test, Zero or | PSHA PSHB PULA PULB ROL ROLA RORB RORB SBCA SBCB STAA STAA STAA STAS STD SUBA SUBB SUBB TAB | 80 CO | 2 2 2 2 2 | 2 2 2 2 2 2 | 92 D2 97 D7 DD 90 D0 | 3 3 3 3 4 3 3 | 2 | 69 66 A2 E2 A7 E7 ED A0 E0 A3 | 6 6 4 4 4 4 5 4 4 6 6 | 2 2 2 2 2 2 2 2 | 79 76 82 F2 B7 F7 FD B0 F0 B3 | 6 6 4 4 4 5 4 4 6 | 3 3 3 3 3 3 3 3 3 3 | 37 32 33 49 59 46 56 10 | 2 | 1 | B + M → B A → Stack B → Stack Stack → A Stack + B C → □ □ □ □ □ □ D → □ □ □ C → □ □ □ □ D → □ □ □ C → □ □ □ □ D → □ □ □ D → □ □ □ D → □ □ □ D → □ □ □ D → □ □ □ D → □ □ □ □ D → □ □ □ □ D → □ □ □ □ □ D → □ □ □ □ □ D → □ □ □ □ □ D → □ □ □ □ □ □ D → □ □ □ □ □ □ D → □ □ □ □ □ □ D → □ □ □ □ □ □ D → □ □ □ □ □ □ D → □ □ □ □ □ □ D → □ □ □ □ □ □ D → □ □ □ □ □ □ D → □ □ □ □ □ □ D → □ □ □ □ □ □ D → □ □ □ □ □ □ □ D → □ □ □ □ □ □ □ D → □ □ □ □ □ □ □ D → □ □ □ □ □ □ □ D → □ □ □ □ □ □ □ D → □ □ □ □ □ □ □ D → □ □ □ □ □ □ □ D → □ □ □ □ □ □ □ D → □ □ □ □ □ □ □ D → □ □ □ □ □ □ □ D → □ □ □ □ □ □ □ D → □ □ □ □ □ □ □ □ D → □ □ □ □ □ □ □ □ D → □ □ □ □ □ □ □ □ □ D → □ □ □ □ □ □ □ □ □ □ □ D → □ □ □ □ □ □ □ □ □ □ □ □ D → □ □ □ □ □ □ □ □ □ □ □ □ □ □ □ □ □ □ | | | | | • | R R R R R | |
| Pull Data Rotate Left Rotate Right Subtract Acmitr Subtract with Carry Store Acmitrs Subtract Subtra | PSHA PSHB PULB ROL ROLB ROR RORA RORA SBCA SBCA SBCA STAB STAB STD SUBB SUBB SUBB SUBB SUBB SUBB SUBB SUB | 80 CO | 2 2 2 2 2 | 2 2 2 2 2 2 | 92 D2 97 D7 DD 90 D0 | 3 3 3 3 4 3 3 | 2 | 69 66 A2 E2 A7 E7 ED A0 E0 A3 | 6 6 4 4 4 4 5 4 4 6 6 | 2 2 2 2 2 2 2 2 | 79 76 82 F2 B7 F7 FD B0 F0 B3 | 6 6 4 4 4 5 4 4 6 | 3 3 3 3 3 3 3 3 3 3 | 37 32 33 49 59 46 56 10 | 2 | 1 | B + M + B A + Stack B + Stack Stack + A Stack + B C → D ← C D ← | | | | | • | | |

The Condition Code Register symbol explanations are listed after Table 11

TABLE 11 - JUMP AND BRANCH INSTRUCTIONS

| | | Π | | | | | | Π | | | | | | П | | | | Co | onc | | Cod | e I | Reg | g. 1 |
|--------------------------|----------|----|------------|---|----|------|---|----|----------|---|----|-----|---|----|------|-----|---------------------------|----|-----|---|-----|-----|-----|------|
| | | _ | ire | | | elat | | _ | nde | | _ | xtn | _ | _ | here | ent | | 5 | 4 | 3 | | | T | 0 |
| Operations | Mnemonic | OP | <u> </u> ~ | # | | | | OP | <u>'</u> | # | OP | ~ | # | OP | ~ | # | Branch Test | Н | 1 | N | Z | 1 | / 0 | С |
| Branch Always | BRA | | Г | | 20 | 3 | 2 | | | | | | | | Г | Γ | None | • | • | | • | • | T | • |
| Branch Never | BRN | | | | 21 | 3 | 2 | | | | | | | | Π | Г | None | • | • | • | | 1 | T | • |
| Branch If Carry Clear | BCC | | Γ | | 24 | 1 | 1 | 1 | | | | | | | Π | Г | C = 0 | • | • | | • | 1 | T | • |
| Branch If Carry Set | BCS | | | | 25 | 3 | 2 | | | | | Π | Γ | Γ | Π | Γ | C = 1 | • | • | • | | • | | • |
| Branch If = Zero | BEQ | | Γ | Γ | 27 | 3 | 2 | | Г | Γ | | | Γ | | Г | Г | Z = 1 | • | • | • | | • | 1 | • |
| Branch If ≥ Zero | BGE | Π | Γ | Г | 2C | 3 | 2 | | Г | Г | | Г | Γ | Г | | Γ | N⊕V = 0 | • | • | • | | 1 | 1 | • |
| Branch If > Zero | BGT | | Г | Г | 2E | 3 | 2 | Π | Г | | Г | | Г | Г | T | Т | Z + (N ⊕ V) = 0 | • | • | | | • | , | • |
| Branch If Higher | вні | Г | Γ | Γ | 22 | 3 | 2 | Γ | Π | | | Г | Г | Γ | Τ | T | C + Z = 0 | • | • | • | • | • | | • |
| Branch If Higher or Same | BHS | | Γ | Γ | 24 | 3 | 2 | Π | Г | | | Г | Γ | | T | Т | C = 0 | • | • | • | | • | , | • |
| Branch If ≤ Zero | BLE | | | | 2F | 3 | 2 | | | | | | | | T | | Z + (N ⊕ V) = 1 | • | • | • | | 1 | 1 | • |
| Branch If Carry Set | BLO | | | | 25 | 3 | 2 | Γ | Π | | Г | | Г | | Г | | C = 1 | • | • | | • | • | न | P |
| Branch If Lower Or Same | BLS | | | | 23 | | 2 | | | | | | | | | | C + Z = 1 | • | • | • | • | • | • | • |
| Branch If < Zero | BLT | | | | 2D | 3 | 2 | Π | П | | | П | Г | | Г | П | N⊕V = 1 | • | • | | | • | | , |
| Branch If Minus | BMI | | | Г | 2B | 3 | 2 | Г | | | | П | | | | П | N = 1 | • | • | • | | • | | • |
| Branch If Not Equal Zero | BNE | | | | 26 | 3 | 2 | Г | | | | | Г | | Г | П | Z = 0 | • | • | | | • | • | • |
| Branch If Overflow Clear | BVC | | | | 28 | 3 | 2 | | | | | | | | Г | П | V = 0 | • | • | | | • | | • |
| Branch If Overflow Set | BVS | | | | 29 | 3 | 2 | | | | | П | Г | | Г | П | V = 1 | • | | | • | • | , | • |
| Branch If Plus | BPL | | | Г | 2A | 3 | 2 | Π | | | | | | | Γ | П | N = 0 | • | • | 9 | | | 1 | • |
| Branch To Subroutine | BSR | | | | 8D | 6 | 2 | | | | | | | | | П |) See Special | • | • | • | • | | , (| • |
| Jump | JMP | | | | | Γ | Π | 6E | 3 | 2 | 7E | 3 | 3 | | Π | П | Operations | • | • | • | | • | 1 | , |
| Jump To Subroutine | JSR | 9D | 5 | 2 | | Γ | Г | AD | 6 | 2 | BD | 6 | 3 | | Г | П | Figure 27 | • | • | • | • | • | | • |
| No Operation | NOP | | | | | | Γ | Г | | | | | Г | 01 | 2 | 1 | | • | | • | | | | • |
| Return From Interrupt | RTI | | | | | | Γ | Π | Γ | | | П | | ЗВ | 10 | 1 | ` | 1 | T | T | 1 | 1 | 17 | Г |
| Return From Subroutine | RTS | | | | | T | T | 1 | Г | | | П | Г | 39 | 5 | 1 | See Special | • | • | • | • | t | 1 | , |
| Software Interrupt | SWI | | | | | | Г | Г | Γ | | | П | Γ | 3F | 12 | 1 | Operations - Figure 27 | • | s | • | • | | | , |
| Wait For Interrupt | WAI | | | | | Γ | Γ | | | | | П | | 3E | 9 | 1 | yga. o z . | • | • | • | • | | | , |

TABLE 12 - CONDITION CODE REGISTER MANIPULATION INSTRUCTIONS

| | | | | C | one | i C | ode | Re | g | | |
|----------------------|----------|----|---|---|-------------------|-----|-----|----|---|---|----|
| | Inherer | nt | | | | 5 | 4 | 3 | 2 | 1 | 0 |
| Operations | Mnemonic | OP | ~ | # | Boolean Operation | Н | Ī | 2 | Z | V | С |
| Clear Carry | CLC | ОС | 2 | 1 | 0 - C | • | • | • | • | | R |
| Clear Interrupt Mask | CLI | 0E | 2 | 1 | 0 -1 | • | R | • | • | • | • |
| Clear Overflow | CLV | 0A | 2 | 1 | 0 - V | • | • | • | • | R | • |
| Set Carry | SEC | OD | 2 | 1 | 1 - C | • | • | • | • | • | s |
| Set Interrupt Mask | SEI | OF | 2 | 1 | 1 -1 | • | s | • | | • | • |
| Set Overflow | SEV | ОВ | 2 | 1 | 1 - V | • | • | • | • | s | • |
| Accumulator A - CCR | TAP | 06 | 2 | 1 | A - CCR | T | T | T | 1 | T | IT |
| CCR - Accumulator A | TPA | 07 | 2 | 1 | CCR A | | • | • | | • | • |

LEGEND

- OP Operation Code (Hexadecimal)
- ~ Number of MPU Cycles

MSP Contents of memory location pointed to by Stack Pointer

- # Number of Program Bytes
- + Arithmetic Plus
- Arithmetic Minus
- Boolean AND
- X Arithmetic Multiply
- + Boolean Inclusive OR
- ⊕ Boolean Exclusive OR
- M Complement of M - Transfer Into
- 0 Bit = Zero
- 00 Byte = Zero

CONDITION CODE SYMBOLS

- H Half-carry from bit 3
- I Interrupt mask
- N Negative (sign bit)
- Z Zero (byte)
 V Overflow, 2's complement
- C Carry/Borrow from MSB
- R Reset Always
- S Set Always
- Affected
 Not Affected

TABLE 13 - INSTRUCTION EXECUTION TIMES IN E-CYCLES

| | l | ADI | DRESSI | NG MO | DE | |
|--|-----------------------|------------------|----------------------------|----------------------------|----------------------------|--|
| | Immediate | Direct | Extended | Indexed | Inherent | Relative |
| ABA ABX ADC ADD ADDD AND ASL ASLD ASR BCC | 2 2 4 2 • | 3 3 5 3 | 4 4 4 6 4 6 | 4 4 6 4 6 | 2 3 | • • • |
| BCS BEQ BGE BGT BHI BHS BIT BLE BLO | • | 3 | • | • | • | 3 3 3 3 3 • |
| BLO BLS BLT BMI BNE BPL BRA BRN BSR BVC | • | • | • | • | • | 3 3 3 3 3 3 3 3 6 3 |
| BVS CBA CLC CLI CLR CLV CMP | • | • | 6 | 6 | 2 2 2 2 2 | 3 |
| COM CPX DAA DEC DES DEX EOR INC | 4 | 5 | 6 6 6 • 4 6 | 6 6 6 • 4 6 | 2 2 2 3 3 • | • |

| | | ADD | RESSIN | IG MO | DE | |
|------|---|----------------------------|-------------|------------------|---|----------|
| | Immediate | Direct | Extended | Indexed | Inherent | Relative |
| INX | • | • | • | • | 3 | • |
| JMP | • | • | 3 | 3 | • | |
| JSR | • | 5 | 6 | 6 | • | • |
| LDA | 2 | 3 | 3 6 4 | 6 4 | • | |
| LDD | 3 | 4 | 5 | 5 | • | • |
| LDS | 3 | 4 | 5 | 5 | • | • |
| LDX | 3 | 4 | 5 | 5 | • | • |
| LSL | 2 3 3 3 | 5 3 4 4 4 4 | 6 | 6 | 2 | |
| LSLD | • | • | • | • | 2 3 2 3 10 2 2 2 3 4 4 5 2 2 | • |
| LSR | • | • | 6 | 6 | 2 | • |
| LSRD | | • | • | • | 3 | • |
| MUL | • | • | • | • | 10 | • |
| NEG | • | • | 6 | 6 | 2 | • |
| NOP | • | • | • | • | 2 | • |
| ORA | 2 | 3 | 4 | 4 | • | • |
| PSH | • | • | • | • | 3 | • |
| PSHX | • | • | • | • | 4 | • |
| PUL | • | • | • | • | 4 | • |
| PULX | • | • | | • | 5 | • |
| ROL | • | • | 6 | 6 | 2 | • |
| ROR | • | • | 6 | 6 6 | 2 | • |
| RTI | • | • | • | • | 10 | • |
| RTS | • | • | • | • | 5 | • |
| SBA | • | • | • | • | 2 | • |
| SBC | 2 | 3 | 4 | 4 | • | • |
| SEC | • | • | • | • | 2 | • |
| SEI | • | • | • | • | 2 | • |
| SEV | • | 3 | • | • | 2 | • |
| STA | 2 | 3 | 4 | 4 | 2 2 2 | • |
| STD | • | 4 | 5 | 5 5 5 4 | • | • |
| STS | • | 4 | 5 | 5 | • | • |
| STX | | 4 | 5 | 5 | • | • |
| SUB | 2 | 3 | 4 | | • | • |
| SUBD | 4 | 5 | 6 | 6 | • | |
| SWI | 2 4 • • • • • • • • • • • • • • • • • • | • | • | • | 12 2 2 2 2 2 2 3 3 | • |
| TAB | • | • | • | • • | 2 | • |
| TAP | • | | • | • | 2 | • |
| TBA | | | • | | 2 | |
| TPA | | | 6 | | 2 | |
| TST | | | 0 | 0 | 2 | |
| TXS | • | • | | | 3 | |
| WAI | • | • | | 6 | 9 | |
| VVAI | • | • | • | • | 8 | _ |

SUMMARY OF CYCLE-BY-CYCLE OPERATION

Table 14 provides a detailed description of the information present on the Address Bus, Data Bus, and the Read/Write (R/W) line during each cycle of each instruction

The information is useful in comparing actual with expected results during debug of both software and hardware as the program is executed. The information is categorized in groups according to addressing mode and number of cycles

per instruction. In general, instructions with the same addressing mode and number of cycles execute in the same manner. Exceptions are indicated in the table.

Note that during MPU reads of internal locations, the resultant value will not appear on the external Data Bus except in Mode 0 "High order" byte refers to the most significant byte of a 16-bit value

TABLE 14 - CYCLE-BY-CYCLE OPERATION

| Address Mode & Instructions | Cycles | Cycle # | Address Bus | R/W Line | Data Bus |
|-----------------------------|--------|------------|------------------------|-------------|----------------------------------|
| IMMEDIATE | | | | | |
| ADC EOR | 2 | 1 | Op Code Address | 1 | Op Code |
| ADD LDA | 1 1 | 2 | Op Code Address + 1 | 1 | Operand Data |
| AND ORA | · | | 1 | | |
| BIT SBC | 1 1 | | 1 | | |
| CMP SUB | | | | | |
| LDS | 3 | 1 | Op Code Address | 1 | Op Code |
| LDX | 1 1 | 2 | Op Code Address + 1 | 1 | Operand Data (High Order Byte) |
| LDD | _ 1 | 3 | Op Code Address + 2 | 1 | Operand Data (Low Order Byte) |
| CPX | 4 | 1 | Op Code Address | 1 | Op Code |
| SUBD | | 2 | Op Code Address + 1 | 1 | Operand Data (High Order Byte) |
| ADDD | 1 1 | 3 | Op Code Address + 2 | 1 | Operand Data (Low Order Byte) |
| <u> </u> | | 4 | Address Bus FFFF | 1 1 | Low Byte of Restart Vector |
| DIRECT | | | | | |
| ADC EOR | 3 | 1 | Op Code Address | 1 | Op Code |
| ADD LDA | 1 | 2 | Op Code Address + 1 | 1 | Address of Operand |
| AND ORA | 1 | 3 | Address of Operand | 1 | Operand Data |
| BIT SBC | 1 1 | | 1 | J | |
| CMP SUB | | | | | |
| STA | 3 | 1 | Op Code Address | 1 | Op Code |
| | } | 2 | Op Code Address + 1 | 1 | Destination Address |
| | | 3 | Destination Address | 0 | Data from Accumulator |
| LDS | 4 | 1 | Op Code Address | 1 | Op Code |
| LDX | 1 1 | 2 | Op Code Address + 1 | 1 | Address of Operand |
| LDD | } } | 3 | Address of Operand | 1 | Operand Data (High Order Byte) |
| | | 4 | Operand Address + 1 | 1 | Operand Data (Low Order Byte) |
| STS | 4 | 1 | Op Code Address | 1 | Op Code |
| STX | 1 1 | 2 | Op Code Address + 1 | 1 | Address of Operand |
| STD | 1 | 3 | Address of Operand | 0 | Register Data (High Order Byte) |
| | | 4 | Address of Operand + 1 | 0 | Register Data (Low Order Byte) |
| CPX | 5 | 1 | Op Code Address | 1 | Op Code |
| SUBD | | 2 | Op Code Address + 1 | 1 | Address of Operand |
| ADDD | 1 | 3 | Operand Address | 1 | Operand Data (High Order Byte) |
| | | 4 | Operand Address + 1 | 1 | Operand Data (Low Order Byte) |
| | | 5 | Address Bus FFFF | 1 | Low Byte of Restart Vector |
| JSR | 5 | 1 | Op Code Address | 1 | Op Code |
| | | 2 | Op Code Address + 1 | 1 | Irrelevant Data |
| | | 3 | Subroutine Address | 1 | First Subroutine Op Code |
| | | 4 | Stack Pointer | 0 | Return Address (Low Order Byte) |
| | | 5 | Stack Pointer + 1 | 0 | Return Address (High Order Byte) |

- Continued -

TABLE 14 - CYCLE-BY-CYCLE OPERATION (CONTINUED)

| Address Mode & | T_{\bullet} | Cycle | T | R/W | |
|----------------|---------------|-------|--|------|--|
| Instructions | Cycles | # | Address Bus | Line | Data Bus |
| EXTENDED | | | | | |
| JMP | 3 | 1 | Op Code Address | 1 | Op Code |
| | 1 | 2 | Op Code Address + 1 | 1 | Jump Address (High Order Byte) |
| | 1 1 | 3 | Op Code Address + 2 | 1 | Jump Address (Low Order Byte) |
| ADC EOR | 4 | 1 | Op Code Address | 1 | Op Code |
| ADD LDA | | 2 | Op Code Address + 1 | 1 | Address of Operand |
| AND ORA | 1 1 | 3 | Op Code Address + 2 | 1 | Address of Operand |
| | 1 1 | | | | (Low Order Byte) |
| BIT SBC | 1 1 | 4 | Address of Operand | 1 | Operand Data |
| CMP SUB | | | | | |
| STA | 4 | 1 | Op Code Address | 1 | Op Code |
| | 1 1 | 2 | Op Code Address + 1 | 1 | Destination Address |
| | 1 1 | | | | (High Order Byte) |
| | } } | 3 | Op Code Address + 2 | 1 | Destination Address |
| | 1 1 | 4 | Operand Destination Address | 0 | (Low Order Byte) Data from Accumulator |
| 100 | 5 | 1 | | | |
| LDS | " | 2 | Op Code Address Op Code Address + 1 | 1 1 | Op Code Address of Operand |
| LDX | 1 1 | 2 | Op Code Address + 1 | ' | (High Order Byte) |
| LDD | 1 1 | 3 | Op Code Address + 2 | 1 | Address of Operand |
| 100 | 1 1 | J | op code Address 2 | ' | (Low Order Byte) |
| | 1 1 | 4 | Address of Operand | 1 | Operand Data (High Order Byte) |
| | 1 1 | 5 | Address of Operand + 1 | 1 | Operand Data (Low Order Byte) |
| STS | 5 | 1 | Op Code Address | 1 | Op Code |
| STX | 1 1 | 2 | Op Code Address + 1 | 1 1 | Address of Operand |
| | 1 1 | | | | (High Order Byte) |
| STD | | 3 | Op Code Address + 2 | 1 | Address of Operand |
| | 1 | | 1 | i i | (Low Order Byte) |
| | 1 1 | 4 | Address of Operand | 0 | Operand Data (High Order Byte) |
| | | 5 | Address of Operand + 1 | 0 | Operand Data (Low Order Byte) |
| ASL LSR | 6 | 1 | Op Code Address | 1 | Op Code |
| ASR NEG | | 2 | Op Code Address + 1 | 1 | Address of Operand |
| |) | _ | 1 | 1 | (High Order Byte) |
| CLR ROL | 1 1 | 3 | Op Code Address + 2 | 1 | Address of Operand |
| | 1 1 | 4 | 1 | ١. | (Low Order Byte) |
| COM ROR | | 5 | Address of Operand Address Bus FFFF | 1 1 | Current Operand Data |
| DEC TST INC | | 6 | Address of Operand | | Low Byte of Restart Vector New Operand Data |
| CPX | 6 | 1 | Op Code Address | 1 | Op Code |
| SUBD | 1 ' 1 | 2 | Op Code Address + 1 | l i | Operand Address |
| 3000 | 1 | _ | Op code Address 1 | ' | (High Order Byte) |
| ADDD | - | 3 | Op code Address + 2 | 1 | Operand Address |
| | 1 1 | • | op state / nameste | 1 ' | (Low Order Byte) |
| | 1 1 | 4 | Operand Address | 1 | Operand Data (High Order Byte) |
| | | 5 | Operand Address + 1 | 1 | Operand Data (Low Order Byte) |
| | 1 1 | 6 | Address Bus FFFF | 1 | Low Byte of Restart Vector |
| JSR | 6 | 1 | Op Code Address | 1 | Op Code |
| | | 2 | Op Code Address + 1 | 1 | Address of Subroutine |
| | | | l | 1 | (High Order Byte) |
| | 1 1 | 3 | Op Code Address + 2 | 1 | Address of Subroutine |
| | | | | | (Low Order Byte) |
| | | 4 | Subroutine Starting Address | 1 | Op Code of Next Instruction |
| | | 5 | Stack Pointer | 0 | Return Address |
| | | 6 | Stack Pointer - 1 | 10 | (Low Order Byte) |
| | | O | Stack Folliter - 1 | 10 | Return Address |
| | | | | | (High Order Byte) |

- Continued -

TABLE 14 — CYCLE-BY-CYCLE OPERATION (CONTINUED)

| Address Mode & Instructions | Cycles | Cycle # | Address Bus | R/W Line | Data Bus |
|-----------------------------|--------|------------|--------------------------------|-------------|----------------------------------|
| INDEXED | | | | | |
| JMP | 3 | 1 | Op Code Address | 1 | Op Code |
| | 1 1 | 2 | Op Code Address + 1 | 1 | Offset |
| | | 3 | Address Bus FFFF | 1 | Low Byte of Restart Vector |
| ADC EOR | 4 | 1 | Op Code Address | 1 | Op Code |
| ADD LDA | 1 1 | 2 | Op Code Address + 1 | 1 | Offset |
| AND ORA | 1 1 | 3 | Address Bus FFFF | 1 | Low Byte of Restart Vector |
| BIT SBC | 1 | 4 | Index Register Plus Offset | 1 | Operand Data |
| CMP SUB | | | | ł | |
| STA | 4 | 1 | Op Code Address | 1 | Op Code |
| | 1 1 | 2 | Op Code Address + 1 | 1 | Offset |
| | | 3 | Address Bus FFFF | 1 | Low Byte of Restart Vector |
| | 1 1 | 4 | Index Register Plus Offset | 0 | Operand Data |
| LDS | 5 | 1 | Op Code Address | 1 | Op Code |
| LDX | | 2 | Op Code Address + 1 | 1 | Offset |
| LDD | 1 1 | 3 | Address Bus FFFF | 1 | Low Byte of Restart Vector |
| | | 4 | Index Register Plus Offset | 1 | Operand Data (High Order Byte) |
| | 1 1 | 5 | Index Register Plus Offset + 1 | 1 | Operand Data (Low Order Byte) |
| STS | 5 | 1 | Op Code Address | 1 | Op Code |
| STX | | 2 | Op Code Address + 1 | 1 1 | Offset |
| STD | 1 | 3 | Address Bus FFFF | 1 | Low Byte of Restart Vector |
| | 1 1 | 4 | Index Register Plus Offset | 0 | Operand Data (High Order Byte) |
| | 1 1 | 5 | Index Register Plus Offset + 1 | 0 | Operand Data (Low Order Byte) |
| ASL LSR | 6 | 1 | Op Code Address | 1 | Op Code |
| ASR NEG | 1 1 | 2 | Op Code Address + 1 | 1 1 | Offset |
| CLR ROL | 1 1 | 3 | Address Bus FFFF | 1 1 | Low Byte of Restart Vector |
| COM ROR | 1 1 | 4 | Index Register Plus Offset | 1 | Current Operand Data |
| DEC TST (1) | 1 1 | 5 | Address Bus FFFF | 1 | Low Byte of Restart Vector |
| INC | 1 1 | 6 | Index Register Plus Offset | 0 | New Operand Data |
| CPX | 6 | 1 | Op Code Address | 1 | Op Code |
| SUBD | 1 | 2 | Op Code Address + 1 | 1 | Offset |
| ADDD | 1 1 | 3 | Address Bus FFFF | 1 | Low Byte of Restart Vector |
| | | 4 | Index Register + Offset | 1 | Operand Data (High Order Byte) |
| | 1 | 5 | Index Register + Offset + 1 | 1 | Operand Data (Low Order Byte) |
| | 1 1 | 6 | Address Bus FFFF | } | Low Byte of Restart Vector |
| JSR | 6 | 1 | Op Code Address | 1 | Op Code |
| | 1 | 2 | Op Code Address + 1 | 1 | Offset |
| | 1 | 3 | Address Bus FFFF | 1 | Low Byte of Restart Vector |
| | 1 1 | 4 | Index Register + Offset | 1 | First Subroutine Op Code |
| | 1 | 5 | Stack Pointer | 0 | Return Address (Low Order Byte) |
| | 1 | 6 | Stack Pointer - 1 | 0 | Return Address (High Order Byte) |

— Continued —

TABLE 14 — CYCLE-BY-CYCLE OPERATION (CONTINUED)

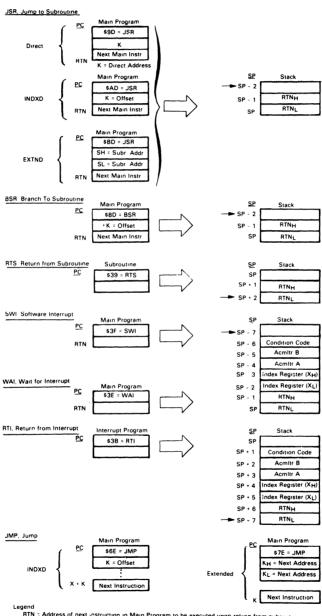
| Address Mode & Instructions | Cycles | Cycle # | Address Bus | R/W Line | Data Bus |
|---|--------|----------------------------|---|------------------|---|
| INHERENT | | | | | |
| ABA DAA SEC ASL DEC SEI ASR INC SEV CBA LSR TAB CLC NEG TAP CLI NOP TBA CLR ROL TPA CLV ROR TST COM SBA | 2 | 1 2 | Op Code Address Op Code Address +1 | 1 1 | Op Code Op Code of Next Instruction |
| ABX | 3 | 1 2 3 | Op Code Address Op Code Address +1 Address Bus FFFF | 1 1 1 | Op Code Irrelevent Data Low Byte of Restart Vector |
| ASLD LSRD | 3 | 1 2 3 | Op Code Address Op Code Address +1 Address Bus FFFF | 1 1 1 | Op Code Irrelevant Data Low Byte of Restart Vector |
| DES INS | 3 | 1 2 3 | Op Code Address Op Code Address +1 Previous Register Contents | 1 1 1 | Op Code Op Code of Next Instruction Irrelevant Data |
| DEX | 3 | 1 2 3 | Op Code Address Op Code Address +1 Address Bus FFFF | 1 1 1 | Op Code Op Code of Next Instruction Low Byte of Restart Vector |
| PSHA PSHB | 3 | 1 2 3 | Op Code Address Op Code Address +1 Stack Pointer | 1 1 0 | Op Code Op Code of Next Instruction Accumulator Data |
| TSX | 3 | 1 2 3 | Op Code Address Op Code Address +1 Stack Pointer | 1 1 1 | Op Code Op Code of Next Instruction Irrelevant Data |
| TXS | 3 | 1 2 3 | Op Code Address Op Code Address +1 Address Bus FFFF | 1 1 1 | Op Code Op Code of Next Instruction Low Byte of Restart Vector |
| PULA PULB | 4 | 1 2 3 4 | Op Code Address Op Code Address +1 Stack Pointer Stack Pointer +1 | 1 1 1 1 | Op Code Op Code of Next Instruction Irrelevant Data Operand Data from Stack |
| PSHX | 4 | 1 2 3 4 | Op Code Address Op Code Address +1 Stack Pointer Stack Pointer -1 | 1 1 0 0 | Op Code Irrelevant Data Index Register (Low Order Byte) Index Register (High Order Byte) |
| PULX | 5 | 1 2 3 4 5 | Op Code Address Op Code Address +1 Stack Pointer Stack Pointer +1 Stack Pointer +2 | 1 1 1 1 1 | Op Code Irrelevant Data Irrelevant Data Index Register (High Order Byte) Index Register (Low Order Byte) |
| RTS | 5 | 1 2 3 4 | Op Code Address Op Code Address +1 Stack Pointer Stack Pointer +1 Stack Pointer +2 | 1 1 1 | Op Code Irrelevant Data Irrelevant Data Address of Next Instruction (High Order Byte) Address of Next Instruction (Low Order Byte) |
| WAI | 9 | 1 2 3 4 5 6 | Op Code Address Op Code Address +1 Stack Pointer Stack Pointer -1 Stack Pointer -2 Stack Pointer -3 | 1 1 0 0 | Op Code Op Code of Next Instruction Return Address (Low Order Byte) Return Address (High Order Byte) Index Register (Low Order Byte) Index Register (High Order Byte) |
| | | 7 8 9 | Stack Pointer -4 Stack Pointer -5 Stack Pointer -6 | 0 0 0 | Contents of Accumulator A Contents of Accumulator B Contents of Cond Code Register |

- Continued -

TABLE 14 - CYCLE-BY-CYCLE OPERATION (CONCLUDED)

| Address Mode & Instructions | Cycles | Cycle # | Address Bus | R/W Line | Data Bus |
|---|--------|---|-----------------------------|---|---|
| INHERENT | | *************************************** | | | |
| MUL | 10 | 1 | Op Code Address | 1 1 | Op Code |
| | 1 | 2 | Op Code Address +1 | 1 1 | Irrelevant Data |
| | 1 | 3 | Address Bus FFFF | 1 | Low Byte of Restart Vector |
| | 1 | 4 | Address Bus FFFF | 1 | Low Byte of Restart Vector |
| | I | 5 | Address Bus FFFF | 1 | Low Byte of Restart Vector |
| | 1 | 6 | Address Bus FFFF | 1 | Low Byte of Restart Vector |
| | | 7 | Address Bus FFFF | 1 | Low Byte of Restart Vector |
| | 1 | 8 | Address Bus FFFF | 1 | Low Byte of Restart Vector |
| | 1 | 9 | Address Bus FFFF | 1 1 | Low Byte of Restart Vector |
| | | 10 | Address Bus FFFF | 1 | Low Byte of Restart Vector |
| RTI | 10 | 1 | Op Code Address | 1 | Op Code |
| | | 2 | Op Code Address +1 | 1 | Irrelevant Data |
| | | 3 | Stack Pointer | 1 | Irrelevant Data |
| | | 4 | Stack Pointer +1 | 1 | Contents of Cond Code Reg from Stack |
| | | 5 | Stack Pointer +2 | 1 | Contents of Accumulator B from Stack |
| | | 6 | Stack Pointer +3 | 1 | Contents of Accumulator A from Stack |
| | | 7 | Stack Pointer +4 | 1 | Index Register from Stack (High Order Byte) |
| | | 8 | Stack Pointer +5 | 1 | Index Register from Stack |
| | | 9 | Stack Pointer +6 | 1 | (Low Order Byte) Next Instruction Address from |
| | | 10 | Stack Pointer +7 | 1 | Stack (High Order Byte) Next Instruction Address from |
| | 1 | | | لــــــــــــــــــــــــــــــــــــــ | Stack (Low Order Byte) |
| SWI | 12 | 1 | Op Code Address | 1 1 | Op Code |
| | 1 | 2 | Op Code Address +1 | 1 1 | Irrelevant Data |
| | 1 | 3 | Stack Pointer | 0 | Return Address (Low Order Byte) |
| | | 4 | Stack Pointer -1 | 0 | Return Address (High Order Byte) |
| | 1 | 5 | Stack Pointer -2 | 0 | Index Register (Low Order Byte) |
| | 1 | 6 | Stack Pointer -3 | 0 | Index Register (High Order Byte) |
| | 1 | 7 | Stack Pointer -4 | 0 | Contents of Accumulator A |
| | 1 | 8 | Stack Pointer -5 | 0 | Contents of Accumulator B |
| | 1 | 9 | Stack Pointer -6 | 0 | Contents of Cond Code Register |
| | 1 | 10 | Stack Pointer -7 | 1 | Irrelevant Data |
| | | 11 | Vector Address FFFA (Hex) | 1 | Address of Subroutine (High Order Byte) |
| | | 12 | Vector Address FFFB (Hex) | 1 | Address of Subroutine (Low Order Byte) |
| BCC BHT BNE BLO | 3 | 1 | Op Code Address | 1 | Op Code |
| BCS BLE BPL BHS | 1 | 2 | Op Code Address +1 | 1 | Branch Offset |
| BEQ BLS BRA BRN BGE BLT BVC BGT BMT BVS | | 3 | Address Bus FFFF | 1 | Low Byte of Restart Vector |
| BSR | 6 | 1 | Op Code Address | 1 | Op Code |
| | | 2 | Op Code Address +1 | 1 1 | Branch Offset |
| | 1 | 3 | Address Bus FFFF | 1 | Low Byte of Restart Vector |
| | 1 | 4 | Subroutine Starting Address | 1 | Op Code of Next Instruction |
| | 1 | 5 | Stack Pointer | 0 | Return Address (Low Order Byte) |
| | 1 | 6 | Stack Pointer -1 | 0 | Return Address (High Order Byte) |

FIGURE 26 - SPECIAL OPERATIONS



RTN = Address of next instruction in Main Program to be executed upon return from subroutine

RTNH = Most significant byte of Return Address RTNL = Least significant byte of Return Address
== Stack Pointer After Execution

K 8 bit Unsigned Value

EPROM PROGRAMMING ROUTINE

| PAGE | 001 | EPROM | -SA:1 | EPROM | *** RO | UTINE ' | ro prog | RAM | THE 1 | MC68701 | EPROM | *** | |
|----------------|-----|-------|-------|------------|-----------|-----------|--------------------|---------|----------|---------|-----------|-------------------|----|
| 00001 00002 | | | | NAM OPT | | PROM | =80 | | | | | | |
| 00003 | | | | TTL | | | | PROG | RAM T | THE MC6 | 8701 E | PROM ** | |
| 00004 | | | | | | | | | | | | | |
| 00005 | | | | ****** | ***** | ***** | ***** | **** | **** | ***** | ***** | ***** | |
| 00006 | | | * | | | | | | 2011 | | | | |
| 00007 00008 | | | * | EPRO | M | | -REENTR 68701 E | | | TINE 1 | ro Pro | GRAM | |
| 00009 | | | * | | | THE PIC | 00701 E | i kor | • | | | | |
| 00010 | | | * | | | THE RO | UTINE P | ROGR | AMS ' | THE MC | 68701 E | PROM | |
| 00011 | | | * | | | STARTI | NG AT | ADD | RESS | "PNTF | R" FRO | M A | |
| 00012 | | | * | | | | OF MEMO | | STAR | | AT "IM | BEG" | |
| 00013 00014 | | | * | | | AND EN | DING AT | r "IM | iEND | • | | | |
| 00014 | | | * | CALLING | CONVE | ENTION. | | | | | | | |
| 00016 | | | * | OHELLING | 001111 | 21111011. | | | | | | | |
| 00017 | | | * | JSR | EPRON | M | | | | | | | |
| 00018 | | | * | | | | | | | | | | |
| 00019 | | | * | NOTES: | | | | | | | | | |
| 00020 | | | * | 1. | משים שניי | OUTINE | FYDECTS | S EOI | וחת מז | HRIE RY | ፖፑር T/A | LUES | |
| 00021 | | | * | 1. | | E INITI | | | | O BEIN | | LED. | |
| 00023 | | | * | | | VALUES | | | | | | | |
| 00024 | | | * | | | | | | | | | | |
| 00025 | | | * | | IMBEG | = A DO | | | | | | INTS | |
| 00026 | | | * | | | | HE FIRS | | | O BE | PROGRA | MMED | |
| 00027 | | | * | | | INTO | THE EF | PROM | • | | | | |
| 00029 | | | * | | IMEND | = A DO | UBLE BY | YTE A | ADDRE | SS WH | ICH PO | DINTS | |
| 00030 | | | * | | | | HE LAST | | | | | | |
| 00031 | | | * | | | INTO | THE E | PROM | | | | | |
| 00032 | | | * | | | | | | | | | | |
| 00033 00034 | | | * | | PNTR | | UBLE BY HE FIRS | | | | ICH PO | | |
| 00034 | | | * | | | | RAMMED | | IIE I | N Inc. | EFROM . | IO BE | |
| 00036 | | | * | | | | | - | | | | | |
| 00037 | | | * | | WAIT | | UBLE BY | | | | | | |
| 00038 | | | * | | | | NCTION | | | | | • | |
| 00039 | | | * | | | | ND IS U | | | | | COM- | |
| 00040 | | | * | | | | | | | IVALEN' | | ris i C | |
| 00042 | | | . * | | | | | | (0 | | | | |
| 00043 | | | * | | | 5000 | 00 * (M | CU II | NPUT | FREQ) | / 4 * | 10**6 | |
| 00044 | | | * | | | | | | | | | | |
| 00045 | | | * | | | VALU | ES FOR | TYP | ICAL | INPUT | FREQS | ARE: | |
| 00046 | | | * | | | W | IT | | | MCII | INPUT | FREO | |
| 00048 | | | * | | | | | _ | | | | | |
| 00049 |) | | * | | | 30615 | (\$7797 |) | | | 2.45 M | HZ | |
| 00050 | | | * | | | | (\$C350 | | | | 4.00 M | | |
| 00051 | | | * | | | 61375 | (\$EFBF |) | | | 4.91 M | HZ | |
| 00052 | | | * | 2. | דיד דיב | ASSUMI | ጥ ነው ተ | POU | ER (V | /PP) TC | ΔΥΑΤ | LABLE | |
| 00054 | | | * | 4. | | E RESE | | | | | | LADLE | |
| 00055 | | | * | | | | | | | | | | |
| 00056 | | | * | 3. | THIS | ROUTIN | EPERF | ORMS | NO | ERROR | CHEC | KING. | |
| 00057 | | | * | | | | | | | | | | |
| 00058 | • | | * | | | | | | | | must be d | lone prior to ent | гу |
| | | | | OSE OF F | nobuge | will ensu | re an need | uea int | ıualizat | ion / | | | |

EPROM PROGRAMMING ROUTINE

| PAGE | 002 | E | PRO | M | ۰SA: | 1 EPRO |)M *** | ROUTINE 7 | TO PROGRAM THE MC68701 EPROM *** |
|----------------|-------|-----|-----|------|--------------|----------------|-------------|----------------|---|
| 00060 | | | | | | | | | |
| 00061 | | | | | | * E Q | UATI | E S | |
| 00062 | | | | | | | | | |
| 00063 | | | | 000 | | TCSR | EQU | \$08 | TIMER CONTROL/STAT REGISTER |
| 00064 | | | | 000 | _ | TIMER | EQU | \$09 | COUNTER REGISTER |
| 00065 | | | | 000 | | OUTCMP | • | \$0В | OUTPUT COMPARE REGISTER |
| 00066 | | | | 001 | 4 A | EPMCNT | EQU | \$14 | RAM/EPROM CONTROL REGISTER |
| 00067 | | | | | | | | | |
| 00068 | | | | | | * L O | CAL | VAR | IABLES |
| 00069 | | | | | | | ona | 600 | |
| 00070 | | | | 000 | | TIMES | ORG | \$80 | OWARM OF ASSAULT BY OOK |
| 000712 | | | | 000 | | IMBEG IMEND | RMB RMB | 2 | START OF MEMORY BLOCK LAST BYTE OF MEMORY BLOCK |
| 00072 | | | | 000 | | PNTR | RMB | 2 | FIRST BYTE OF MEMORY BLOCK |
| 000732 | | | | 000 | | WAIT | RMB | 2 | COUNTER VALUE |
| 000742 | 1 000 | 0 | | 000 | 2 A | WALI | KPID | 2 | COUNTER VALUE |
| 00075 | | | | | | * F P | ROM | STAI | RTS HERE |
| 00077 | | | | | | 15 1 | K O H | DIA | |
| 00078 | 300 | n | | | | | ORG | \$3000 | |
| 00079 | | | DE. | 84 | А | EPROM | LDX | PNTR | SAVE CALLING ARGUMENT |
| 00080 | | | | ٠. | •• | 22 11011 | PSHX | | RESTORE WHEN DONE |
| 00081 | | | | 80 | Α | | LDX | IMBEG | USE STACK |
| 00082 | | | | | | | | | |
| 00083 | A 300 |)5 | 3C | | | EPRO02 | PSHX | | SAVE POINTER ON STACK |
| 00084 | A 300 | 6 | 86 | FE | Α | | LDAA | #\$FE | REMOVE VPP, SET LATCH |
| 00085 | A 300 | 8 | 97 | 14 | Α | | STAA | EPMCNT | PPC=1, PLC=0 |
| 00086 | A 300 |)A | Α6 | 00 | Α | | LDAA | X | MOVE DATA MEMORY-TO-LATCH |
| 00087 | A 300 | C | DE | 84 | Α | | LDX | PNTR | GET WHERE TO PUT IT |
| 00088 | A 300 | Œ | Α7 | 00 | Α | | STAA | X | STASH AND LATCH |
| 00089 | A 30 | LO | 80 | | | | INX | | NEXT ADDR |
| 00090 | A 301 | l 1 | DF | 84 | Α | | STX | PNTR | ALL SET FOR NEXT |
| 00091 | | | | | A | | LDAA | #\$FC | ENABLE EPROM POWER (VPP) |
| 00092 | A 301 | 15 | 97 | 14 | A | | STAA | EPMCNT | PPC=0, PLC=0 |
| 00093 | | | | | | | | | |
| 00094 | | | | | | * NOM | WAIT FO | R 50 MSEC | TIMEOUT USING OUTPUT COMPARE. |
| 00095 | | | | | | | | | |
| 00096 | | | | | A | | LDD | WAIT | GET CYCLE COUNTER |
| 00097 | | | | | A | | ADDD | TIMER | BUMP CURRENT VALUE |
| 00098 | | | | | | | CLR | TCSR OUTCMP | CLEAR OCF |
| 00099 00100 | | | | | A A | | STD LDAA | #\$40 | SET OUTPUT COMPARE NOW WAIT FOR OCF |
| 00100 | A 30. | 20 | 00 | 40 | Α | | LDAA | #340 | NOW WALL FOR OCF |
| 00101 | ٧ ٥٠. | າາ | 05 | 00 | | EPRO04 | DITA | TCSR | |
| 00102 | | - | | | | | BEQ | EPRO04 | NOT YET |
| 00104 | | | | rc | 3022 | | PULX | 111004 | SETUP FOR NEXT ONE |
| 00105 | | | | | | | INX | | NEXT |
| 00106 | | | | 82 | Α | | CPX | IMEND | MAYBE DONE |
| 00107 | | | | | | | BLS | EPRO02 | NOT YET |
| 00108 | | | _ | | A | | LDAA | #\$FF | REMOVE VPP, INHIBIT LATCH |
| 00109 | | | | | A | | STAA | EPMCNT | EPROM CAN NOW BE READ |
| 00110 | A 30 | 30 | 38 | | | | PULX | | RESTORE PNTR |
| 00111 | A 30 | 31 | DF | 84 | Α | | STX | PNTR | |
| 00112 | | 33 | 39 | | | | RTS | | THAT'S ALL |
| 00113 | | | | | | | END | | |
| TOTAL | ERR | ORS | 5 0 | 0000 | J 00 | 000 | | | |



MC68705P3

Advance Information

8-BIT EPROM MICROCOMPUTER UNIT

The MC68705P3 Microcomputer Unit (MCU) is an EPROM member of the M6805 Family of low-cost single-chip microcomputers. The user programmable EPROM allows program changes and lower volume applications in comparison to the factory mask programmable versions. The EPROM versions also reduce the development costs and turnaround time for prototype evaluation of the mask ROM versions. This 8-bit microcomputer contains a CPU, on-chip CLOCK, EPROM, bootstrap ROM, RAM, I/O, and a TIMER

Because of these features, the MC68705P3 offers the user an economical means of designing an M6805 Family MCU into his system, either as a prototype evaluation, as a low-volume production run, or a pilot production run

A comparison table of key features for several members of the M6805 Family is shown on the last page of this data sheet

HARDWARE FEATURES:

- 8-Bit Architecture
- 112 bytes of RAM
- Memory Mapped I/O
- 1804 Bytes of User EPROM
- Internal 8-Bit Timer with 7-Bit Prescaler
 - · Programmable Prescaler
 - Programmable Timer Input Modes
- Vectored Interrupts External, Timer, and Software
- Zero-Cross Detection on INT Input
- 20 TTL/CMOS Compatible Bidirectional I/O Lines (8 Lines are LED Compatible)
- On-Chip Clock Generator
- Master Reset
- Complete Development System Support on EXORciser®
- Emulates the MC6805P2 and MC6805P4
- Bootstrap Program in ROM Simplifies EPROM Programming

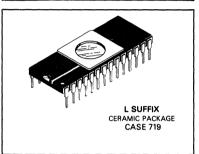
SOFTWARE

- Similar to M6800 Family
- Byte Efficient Instruction Set
- Easy to Program
- True Bit Manipulation
- Bit Test and Branch Instructions
- Versatile Interrupt Handling
- Versatile Index Register
- Powerful Indexed Addressing for Tables
- Full Set of Conditional Branches
- Memory Usable as Registers/Flags
- Single Instruction Memory Examine/Change
- 10 Powerful Addressing Modes
- All Addressing Modes Apply to EPROM, RAM, and I/O

HMOS

(HIGH-DENSITY, N-CHANNEL DEPLETION LOAD, 5 V EPROM PROCESS)

8-BIT EPROM MICROCOMPUTER



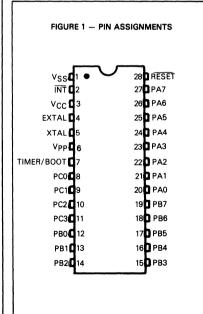


FIGURE 2 - MC68705P3 HMOS MICROCOMPUTER BLOCK DIAGRAM RESET INT XTAL EXTAL Timer/ TIMER/BOOT Prescaler Counter Oscillator Timer Control PRO Accumulator PB1 Port Data Port CPU ►PB3 Dır В Index Control 1/0 ►PR4 Register Rea Reg ►PB5 Lines ►PB6 Condition Port Port Data Code Α Register Dır 1/0 Reg Reg CPU Stack Lines Pointer SF Port Data Port Program C Dir С Counter 1/0 High PCH Reg Reg Lines 1804 X 8 ALU Program **EPROM** Counter Low PCI 115 X 8 Bootstrap ROM 112 X 8 RAM

MAXIMUM RATINGS

| Rating | Symbol | Value | Unit |
|--|------------------|----------------|------|
| Supply Voltage | Vcc | -0.3 to +7.0 | ٧ |
| Input Voltage EPROM Programming Voltage (Vpp Pin) TIMER/BOOT Pin | Vpp | -0 3 to +22 0 | ٧ |
| Normal Mode | V _{in} | -0.3 to $+7.0$ | V |
| Bootstrap Programming Mode | VBOOT | -3 0 to + 15 0 | V |
| All Others | V _{in} | -03 to +70 | V |
| Operating Temperature Range | TA | 0 to +50 | °C |
| Storage Temperature Range | T _{stg} | -55 to +150 | °C |
| Junction Temperature | Tj | + 150 | °C |

This device contains circuitry to protect the inputs against damage due to high static voltages or electric fields, however, it is advised that normal precautions be taken to avoid application of any voltage higher than maximum rated voltages to this high-impedance circuit. For proper operation it is recommended that V_{in} and V_{out} be constrained to the range $V_{SS} \leq (V_{in}$ or $V_{out}) \leq V_{CC}$. Reliability of operation is enhanced if unused inputs are tied to an appropriate logic voltage level (e.g., either V_{SS} or V_{CC})

THERMAL CHARACTERISTICS

| Characteristic | Symbol | Value | Unit |
|--------------------|---------------|-------|------|
| Thermal Resistance | Ī | | |
| Ceramic Package | θ_{JA} | 50 | °C/W |

POWER CONSIDERATIONS

The average chip-junction temperature, T_J, in °C can be obtained from

$$T_J = T_A + (P_D \bullet \theta_{JA})$$

Where:

T_A = Ambient Temperature, °C

θJA = Package Thermal Resistance, Junction-to-Ambient, °C/W

PD = PINT + PPORT

PINT = ICC × VCC, Watts - Chip Internal Power

PPORT = Port Power Dissipation, Watts - User Determined

For most applications PPORT ◀PINT and can be neglected. PPORT may become significant if the device is configured to drive Darlington bases or sink LED loads.

An approximate relationship between PD and TJ (if PPORT is neglected) is:

$$P_D = K + (T_J + 273$$
°C)

(2)

Solving equations 1 and 2 for K gives:

$$K = PD \bullet (TA + 273 °C) + \theta JA \bullet PD^2$$

(3)

(1)

Where K is a constant pertaining to the particular part. K can be determined from equation 3 by measuring PD (at equilibrium) for a known TA. Using this value of K the values of PD and TJ can be obtained by solving equations (1) and (2) iteratively for any value of TA.

PROGRAMMING OPERATION ELECTRICAL CHARACTERISTICS

(V_{CC} = 5 25 Vdc \pm 0 5, V_{SS} = GND, T_A = 20° to 30°C unless otherwise noted)

| Characteristic | Symbol | Min | Тур | Max | Unit |
|--|--------|------|------|---------|------|
| Programming Voltage | Vpp | 20 0 | 21 0 | 22 0 | V |
| Vpp Supply Current Vpp = 5 25 V Vpp = 21 0 V | Ірр | _ | _ | 8 30 | mA |
| Oscillator Frequency | foscp | 09 | 10 | 11 | MHz |
| Bootstrap Programming Mode Voltage (TIMER/BOOT Pin) I _{In} = 100 µA Max | VIHTP | 90 | 12 0 | 15 0 | V |

SWITCHING CHARACTERISTICS (V_{CC} = +5 25 Vdc ±0 5 Vdc, V_{SS} = GND, T_A = 0° to 50° unless otherwise noted)

| Characteristic | Symbol | Min | Тур | Max | Unit |
|--|------------------|------------------------|-----|-----|------|
| Oscillator Frequency Normal | fosc | 0 4 | _ | 4 2 | MHz |
| Instruction Cycle Time (4/f _{OSC}) | tcyc | 0 950 | - | 10 | μS |
| INT, INT2 or Timer Pulse Width | tWL, tWH | t _{CYC} + 250 | - | ·- | ns |
| RESET Pulse Width | tRWL | t _{cyc} + 250 | - | _ | ns |
| RESET Delay Time (External Cap = 1 0 μF) | [†] RHL | 100 | _ | _ | ms |
| INT Zero Crossing Detection Input Frequency (for ±5° Accuracy) | fINT | 0 03 | - | 10 | kHz |
| External Clock Duty Cycle (EXTAL) (See Figure 12) | _ | 40 | 50 | 60 | % |

DC ELECTRICAL CHARACTERISTICS (V_{CC} = +5.25 Vdc, V_{SS} = GND, T_A = 0° to 50° C unless otherwise noted)

| Characteristic | Symbol | Min | Тур | Max | Unit |
|---|-------------------|--|-------------------------|---------------------------------|-------------|
| Input High Voltage RESET (4 75≤ V _{CC} ≤5 75) (V _{CC} <4 75) INT (4 75≤ V _{CC} ≤5 75) (V _{CC} <4 75) All Other | ViH | 40 V _{CC} -05 40 V _{CC} -05 20 | - ** ** | Vcc Vcc Vcc Vcc Vcc | > > |
| Input High Voltage (TIMER/BOOT Pin) Timer Mode Bootstrap Programming Mode | VIН | 2 0 9 0 | - 12 0 | V _{CC} 15 0 | V V |
| Input Low Voltage RESET INT All Other | V _{IL} | -03 -03 -03 | ** | 0 8 1 5 0 8 | V V V |
| Internal Power Dissipation (No Port Loading, V _{CC} =5 25 V, T _A =0°C) | PINT | | 500 | TBD | mW |
| Input Capacitance EXTAL (@ f _{OSC} = 4 0 MHz) All Other | C _{in} | - | 25 10 | - | pF pF |
| RESET Hysteresis Voltage (See Figure 11) Out of Reset Voltage Into Reset Voltage | VIRES+ VIRES- | 2 1 0 8 | - | 4 0 -2 0 | V V |
| Programming Voltage (Vpp Pin) Programming EPROM Operating Mode | V _{PP} * | 20 0 4 0 | 21 0 V _{CC} | 22 0 5 75 | V V |
| Input Current TIMER (V_{In} = 0.4 V) INT (V_{In} = 0.4 V) EXTAL (V_{In} = 0.4 V to V_{CC} Crystal Option) (V_{In} = 0.4 V to V_{CC} Crystal Option) RESET (V_{In} = 0.8 V) (External Capacitor Changing Current) | l ^{IIU} | - - - - -40 | - 20 - - - | 20 50 10 1600 50 | μΑ |

^{*} Vpp is Pin 6 on the MC68705P3 and is connected to V_{CC} in the Normal Operating Mode. In the MC6805P2, Pin 6 is NUM and is connected to V_{SS} in the Normal Operating Mode. The user must allow for this difference when emulating the MC6805P2 ROM-based MCU.

^{**} Due to internal biasing, this input (when not used) floats to approximately 2 0 V

PORT ELECTRICAL CHARACTERISTICS (V_{CC} = +5.25 Vdc, V_{SS} = GND, T_A = 0° to 50° C unless otherwise noted)

| Characteristic | Symbol | Mın | Тур | Max | Unit |
|--|------------------|-----|-------|-------|------|
| | Port A | | | | |
| Output Low Voltage, ILoad = 1 6 mA | V _{OL} | - | - | 0 4 | V |
| Output High Voltage, $I_{Load} = -100 \mu A$ | Voн | 2 4 | - 1 | _ | V |
| Output High Voltage, I _{Load} = -10 μA | Voн | 3 5 | - | _ | V |
| Input High Voltage, ILoad = -300 µA (Max) | V _{IH} | 2 0 | - 1 | VCC | V |
| Input Low Voltage, $I_{Load} = -500 \mu A$ (Max) | V _{IL} | -03 | _ | 0.8 | V |
| Hi-Z State Input Current (V _{In} =20 V to V _{CC}) | ЧН | _ | - | - 300 | μΑ |
| Hi-Z State Input Current (V _{IN} =0 4 V) | li L | | _ | - 500 | μΑ |
| | Port B | | | | |
| Output Low Voltage, ILoad=3 2 mA | VOL | _ | - | 0 4 | V |
| Output Low Voltage, I _{Load} = 10 mA (Sink) | V _{OL} | _ | - | 1 0 | V |
| Output High Voltage, $I_{Load} = -200 \mu A$ | Voн | 2 4 | T - T | _ | V |
| Darlington Current Drive (Source), V _O =15 V | 10Н | -10 | T - 1 | - 10 | mA |
| Input High Voltage | V _{IH} | 2 0 | - | VCC | V |
| Input Low Voltage | V _{IL} | -03 | T - T | 0.8 | V |
| Hi-Z State Input Current | ^I TSI | _ | 2 | 20 | μА |
| | Port C | | | | |
| Output Low Voltage, I _{Load} = 1 6 mA | VOL | | _ | 0 4 | V |
| Output High Voltage, $I_{Load} = -100 \mu A$ | ∨он | 2 4 | - | - | V |
| Input High Voltage | VIH | 2 0 | - | VCC | V |
| Input Low Voltage | V _{IL} | -03 | - | 0.8 | V |
| Hi-Z State Input Current | ^I TSI | _ | 2 | 20 | μΑ |

FIGURE 3 — TTL EQUIVALENT TEST LOAD (PORT B)

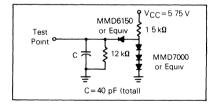


FIGURE 4 — CMOS EQUIVALENT TEST LOAD (PORT A)

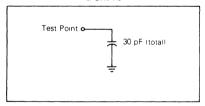
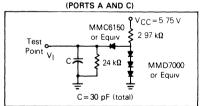


FIGURE 5 - TTL EQUIVALENT TEST LOAD



SIGNAL DESCRIPTION

The input and output signals for the MCU, shown in Figure 1, are described in the following paragraphs

 V_{CC} and V_{SS} — Power is supplied to the MCU using two pins V_{CC} is power and V_{SS} is the ground connection

INT — This pin allows an external event to asynchronously interrupt the processor. It can also be used as a polled input using the BIL and BIH instructions. Refer to INTERRUPTS for additional information.

XTAL and EXTAL — These pins provide connections to the on-chip clock oscillator circuit. A crystal, a resistor, or an external signal, depending on the CLK bit (see MASK OPTIONS), is connected to these pins to provide a system clock source with various stability/cost tradeoffs. Lead lengths and stray capacitance on these two pins should be minimized. Refer to INTERNAL CLOCK GENERATOR OPTIONS for recommendations about these inputs.

 ${\sf TIMER/BOOT}$ — This pin is used as an external input to control the internal timer/circuitry. This pin also detects a

higher voltage level used to initiate the bootstrap program (see PROGRAMMING FIRMWARE) Refer to TIMER for additional information about the timer circuitry.

RESET — This pin has a Schmitt Trigger input and an onchip pullup. The MCU can be reset by pulling RESET low Refer to RESETS for additional information.

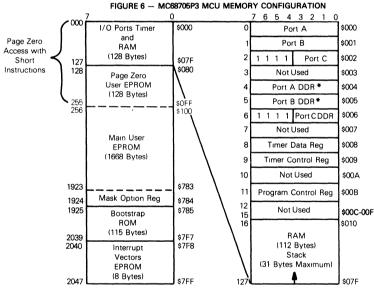
VPP — This pin is used when programming the EPROM By applying the programming voltage to this pin, one of the requirements is met for programming the EPROM. In normal operation, this pin is connected to V_{CC} Refer to PROGRAMMING FIRMWARE and ELECTRICAL CHARACTERISTICS.

INPUT/OUTPUT LINES (PA0-PA7, PB0-PB7, PC0-PC7, PD0-PD7) — These 20 lines are arranged into two 8-bit ports (A and B) and one 4-bit port (C) All lines are programmable as either inputs or outputs, under software control of the Data Direction Registers (DDRs) Refer to INPUT/OUTPUT

paragraphs for additional information, being sure to observe the Caution.

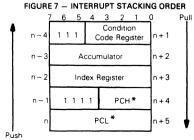
MEMORY

As shown in Figure 6, the MCU is capable of addressing 2048 bytes of memory and I/O registers with its program counter. The MC68705P3 MCU has implemented 2041 bytes of these locations. This consists of 1804 bytes of user EPROM, 115 bytes of bootstrap ROM, 112 bytes of user RAM, an EPROM Mask Option Register (MOR), a Program Control Register (PCR), and eight bytes of I/O. The user EPROM is located in two areas. The main EPROM area is memory locations \$080 to \$783. The second area is reserved for eight interrupt/reset vector bytes at memory locations \$7F8 to \$7FF. The MCU uses nine of the lowest 16 memory locations for program control and I/O features such as ports, the port DDRs, and the timer. The Mask Option Register at memory location \$F38 completes the total. The 112 bytes of user RAM include up to 31 bytes for the stack.



Caution Data Direction Registers (DDRs) are write-only, they read as \$FF

The stack area is used during the processing of interrupt and subroutine calls to save the processor state. The register contents are pushed onto the stack in the order shown in Figure 7. Because the stack pointer decrements during pushes, the low order byte (PCL) of the program counter is stacked first; then the high order three bits (PCH) are stacked. This ensures that the program counter is loaded correctly during pulls from the stack since the stack pointer increments during pulls. A subroutine call results in only the program counter (PCL, PCH) contents being pushed onto the stack, the remaining MCU registers are not pushed.



* For subroutine calls, only PCH and PCL are stacked

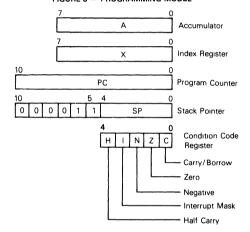
CENTRAL PROCESSING UNIT

The CPU of the M6805 Family is implemented independently from the I/O or memory configuration. Consequently, it can be treated as an independent central processor communicating with I/O and memory via internal address, data, and control buses.

REGISTERS

The M6805 Family CPU has five registers available to the programmer. They are shown in Figure 8 and are explained in the following paragraphs.

FIGURE 8 - PROGRAMMING MODEL



ACCUMULATOR (A) — The accumulator is a general purpose 8-bit register used to hold operands and results of the arithmetic calculations or data manipulations.

INDEX REGISTER (X) — The index register is an 8-bit register used for the indexed addressing mode. It contains an 8-bit value that may be added to an instruction value to create an effective address. The index register can also be used for data manipulations using read/modify/write instructions. The index register may also be used as a temporary storage area.

PROGRAM COUNTER (PC) — The program counter is an 11-bit register that contains the address of the next instruction to be executed.

STACK POINTER (SP) — The stack pointer is an 11-bit register that contains the address of the next free location on the stack. During an MCU reset or the Reset Stack Pointer (RSP) instruction, the stack pointer is set to location \$07F. The stack pointer is then decremented as data is pushed onto the stack and incremented as data is then pulled from the stack. The six most-significant bits of the stack pointer are permanently set to 000011. Subroutines and interrupts may be nested down to location \$061 (31 bytes maximum), which allows the programmer to use up to 15 levels of subroutine calls (less if interrupts are allowed).

CONDITION CODE REGISTER (CC) — The condition code register is a 5-bit register in which four bits are used to indicate the results of the instruction just executed. These bits can be individually tested by a program and specific action taken as a result of their state. Each of the five bits is explained below.

Half Carry (H) — Set during ADD and ADC operations to indicate that a carry occurred between bits 3 and 4

Interrupt (I) — When this bit is set the timer and external interrupt ($\overline{\text{INT}}$) are masked (disabled). If an interrupt occurs while this bit is set, the interrupt is latched and is processed as soon as the interrupt bit is cleared

Negative (N) — When set, this bit indicates that the result of the last arithmetic, logical, or data manipulation was negative (bit 7 in the result is a logical one)

Zero (Z) — When set, this bit indicates that the result of the last arithmetic, logical, or data manipulation was zero.

Carry/Borrow (C) — When set, this bit indicates that a carry or borrow out of the arithmetic logic unit (ALU) occurred during the last arithmetic operation. This bit is also affected during bit test and branch instructions plus shifts and rotates.

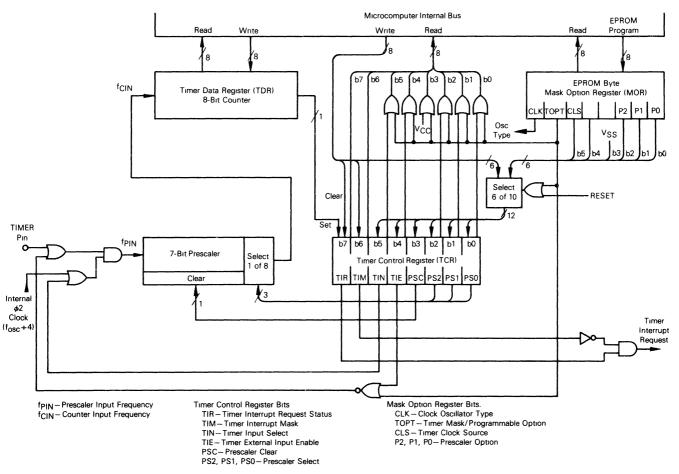
TIMER

The MC68705P3 MCU timer consists of an 8-bit software programmable counter which is driven by a 7-bit prescaler with selectable taps. Various timer clock sources may be selected ahead of the prescaler and counter. The timer selections are made via the Timer Control Register (TCR) and/or the Mask Option Register (MOR). The TCR also contains the interrupt control bits. The sections elsewhere entitled TIMER CONTROL REGISTER and MASK OPTIONS include additional details on controlling this timer.

The MCU timer circuitry is shown in Figure 9. The 8-bit counter may be loaded under program control and is decremented toward zero by the fCIN counter input (output of the prescaler option selection). Once the 8-bit counter has decremented to zero, it sets the TIR (Timer Interrupt Request) bit 7 (b7 of TCR) The TIM (Timer Interrupt Mask) bit (b6) can be software set to inhibit the interrupt request, or software cleared to pass the interrupt request to the processor When the I-bit in the Condition Code Register is cleared, the processor receives the Timer Interrupt. The CPU responds to this interrupt by saving the present CPU state on the stack, fetching the timer interrupt vector from locations \$FF8 and \$FF9 and executing the interrupt routine. The processor is sensitive to the level of the timer interrupt request line, therefore if the interrupt is masked, the TIR bit may be cleared by software (e.g., BCLR) without generating an interrupt. The TIR bit MUST be cleared, by the timer interrupt service routine, to clear the timer interrupt register.

The counter continues to count (decrement) after falling through to \$FF from zero. Thus, the counter can be read at any time by the processor without disturbing the count. This allows a program to determine the length of time since the occurrence of a timer interrupt and does not disturb the counting process.

FIGURE 9 -MC68705P3 TIMER FUNCTIONAL BLOCK DIAGRAM



NOTE. The TOPT bit in the Mask Option Register selects whether the timer is software programmable via the Timer Control Register or emulates the mask programmable ports via the MOR PROM byte

The clock input to the timer can be from an external source (decrementing the counter occurs on a positive transition of the external source) applied to the TIMER input pin, or it can be the internal $\phi 2$ signal. When the $\phi 2$ signal is used as the source, it can be gated by an input applied to the TIMER pin allowing the user to easily perform pulse-width measurements. (Note: When the MOR TOPT bit is set and the CLS bit is clear, an ungated $\phi 2$ clock input is obtained by tying the TIMER pin to VCC) The source of the clock input is selected via the TCR or the MOR as described later.

A prescaler option can be applied to the clock input that extends the timing interval up to a maximum of 128 counts before decrementing the counter. This prescaling TCR or MOR option selects one of eight taps on the 7-bit binary divider, the eighth tap bypasses prescaling. To avoid truncation errors, the prescaler is cleared when bit b3 of the TCR is written to a logic 1, when in the software controlled mode (TOPT=0, more on these modes in later paragraphs). TCR bit b3 always reads as a logic 0 to ensure proper operation with read/modify/write instructions (bit set and clear for example).

At Reset, the prescaler and counter are initialized to an all "1s" condition, the Timer Interrupt Request bit (TCR, b7) is cleared and the Timer Interrupt Request mask (TCR, b6) is set TCR bits b0 through b5 are initialized by the corresponding Mask Option Register (MOR) bits at Reset They are then software selectable after Reset

Note that the timer block diagram in Figure 9 reflects two separate timer control configurations: a) software controlled mode via the Timer Control Register (TCR), and b) MOR controlled mode to emulate a mask ROM version with the Mask Option Register. In the software controlled mode, all TCR bits are read/write, except bit b3 which is write-only (always reads as a logic "0"). In the MOR controlled mode, all TCR bits b7 and b6 are read/write, bit b3 is write-only, and the other five have no effect on a write and read as logic "1s". The two configurations provide the user with the capability to freely select timer options as well as accurately emulate the MC6805P2 and MC6805P4 mask ROM version in the following paragraphs refer to Figure 9 as well as the TIMER CONTROL REGISTER and MASK OPTIONS sections.

The TOPT (Timer Option) bit (b6) in the Mask Option Register is EPROM programmed to a logical "O" to select the software controlled mode, which is described first TCR bits b5, b4, b3, b2, b1, and b0 give the program direct control of the prescaler and input selection options

The Timer Prescaler input (fpIN) can be configured for three different operating modes, plus a disable mode, depending upon the value written to TCR control bits b4 and b5 (TIE and TIN).

When the TIE and TIN bits are programmed to "0", the timer input is from the internal clock (ϕ 2) and TIMER input pin is disabled. The internal clock mode can be used for periodic interrupt generation as well as a reference for frequency and event measurement.

When TIE=1 and TIN=0, the internal clock and the TIMER input pin signals are ANDed to form the timer input fpIN. This mode can be used to measure external pulse wid-

ths The external pulse simply gates in the internal clock for the duration of the pulse. The accuracy of the count in this mode is \pm one count

When TIE=0 and TIN=1, no fpIN input is applied to the prescaler and the timer is disabled.

When TIE and TIN are both programmed to a "1", the timer is from the external clock. The external clock can be used to count external events as well as provide an external frequency for generating periodic interrupts

Bits b0, b1, and b2 in the TCR are program controlled to choose the appropriate prescaler output. The prescaling divides the fpIN frequency by 1, 2, 4, etc. in binary multiples to 128 producing fCIN frequency to the counter. The processor cannot write into or read from the prescaler, however, the prescaler is set to all "15" by a write operation to TCR, b3 (when bit 3 of the written data equals "1"), which allows for truncation-free counting

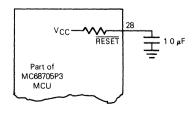
The MOR controlled mode of the timer is selected when the TOPT (Timer Option) bit (b6) in the MOR is programmed to a logical "1" to emulate the mask programmable prescaler of the MC6805P2 and MC6805P4. The timer circuits are the same as described above; however, the Timer Control Register (TCR) is configured differently, as discussed below

The logical level for the functions of bits b0, b1, b2, and b5 in the TCR are all determined at the time of EPROM programming. They are controlled by corresponding bits within the Mask Option Register (MOR, \$F38) The value programmed into MOR bits b0, b1, b2, and b5 controls the prescaler division and the timer clock selection. Bit b4 (TIE) is set to a logical "1" in the MOR controlled mode (When read by software, these five TCR bits always read as logical "1s") As in the software programmable configuration, the TIM (b6) and TIR (b7) bits of the TCR are controlled by the counter and software as described above and in the TIMER CONTROL REGISTER section Bit b3 of the TCR, in the MOR controlled mode, always reads as a logical "0" and can be written to a logical "1" to clear the prescaler. The MOR controlled mode is designed to exactly emulate the MC6805P2 and MC6805P4 which has only TIM and TIR in the TCR and have the prescaler options defined as manufacturing mask options.

RESETS

The MCU can be reset in two ways, by initial power-up, and by the external reset input ($\overline{\text{RESET}}$) Upon power-up, a delay of t_{RHL} is needed before allowing the $\overline{\text{RESET}}$ input to go high. This time allows the internal clock generator to stabilize Connecting a capacitor to the $\overline{\text{RESET}}$ input, as shown in Figure 10, typically provides sufficient delay

FIGURE 10 - POWER-UP RESET DELAY CIRCUIT



The internal circuit connected to the RESET pin consists of a Schmitt trigger which senses the RESET line logic level. The Schmitt trigger provides an internal reset voltage when it senses logical "O" on the RESET pin. During power-up, the Schmitt trigger switches on (removes reset) when the RESET pin voltage rises to VIRES+. When the RESET pin voltage falls to a logical "O" for a period longer than one tcyc, the Schmitt trigger switches off to provide an internal reset voltage. The "switch off" voltage occurs at VIRES-. A typical reset Schmitt trigger hysteresis curve is shown in Figure 11. See Figure 15 for the complete reset sequence.

INTERNAL CLOCK GENERATOR OPTIONS

The internal clock generator circuit is designed to require a minimum of external components. A crystal, a resistor, a jumper wire, or an external signal may be used to generate a system clock with various stability/cost tradeoffs. The Mask

Option Register (EPROM) is programmed to select crystal or resistor operation. The oscillator frequency is internally divided by four to produce the internal system clocks.

The different connection methods are shown in Figure 12

FIGURE 11 — TYPICAL RESET SCHMITT TRIGGER HYSTERESIS

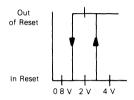
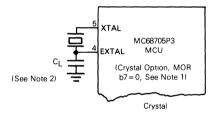
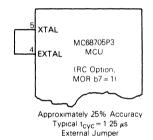
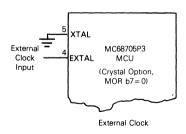
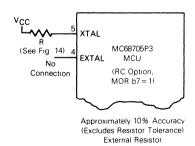


FIGURE 12 - CLOCK GENERATOR OPTIONS







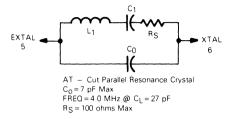


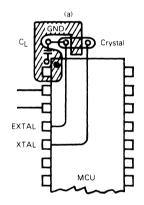
When the TIMER/BOOT input pin is in the V_{IHTP} range (in the bootstrap EPROM programming mode), the crystal option is forced. When the TIMER/BOOT input is at or below V_{CC}, the clock generator option is determined by bit 7 of the Mask Option Register (CLK).
 The recommended C_L value with a 4.0 MHz crystal is 27 pF maximum, including system distributed capacitance. There is an internal.

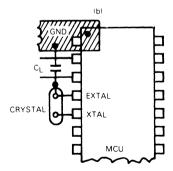
² The recommended C_L value with a 4.0 MHz crystal is 27 pF maximum, including system distributed capacitance. There is an internal capacitance of approximately 25 pF on the XTAL pin. For crystal frequencies other than 4 MHz, the total capacitance on each pin should be scaled as the inverse of the frequency ratio. For example, with a 2 MHz crystal, use approximately 50 pF on EXTAL and approximately 25 pF on XTAL. The exact value depends on the Motional-Arm parameters of the crystal used.

Crystal specifications are given in Figure 13 A resistor selection graph is given in Figure 14

FIGURE 13 — CRYSTAL MOTIONAL-ARM PARAMETERS AND SUGGESTED PC BOARD LAYOUT

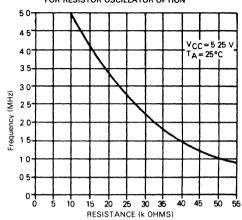






Note Keep crystal leads and circuit connections as short as possible

FIGURE 14 — TYPICAL FREQUENCY SELECTION FOR RESISTOR OSCILLATOR OPTION



The crystal oscillator start-up time is a function of many variables crystal parameters (especially $R_{\text{S}}),$ oscillator load capacitancs, IC parameters, ambient temperature, and supply voltage To ensure rapid oscillator start-up neither the crystal characteristics nor the load capacitances should exceed recommendations

BOOTSTRAP ROM

The bootstrap ROM contains a factory program which allows the MCU to fetch data from an external device and transfer it into the MC68705P3 EPROM. The bootstrap program provides, timing of programming pulses, timing of VPP input, and verification after programming. See PROGRAMMING FIRMWARE section.

MASK OPTION REGISTER (MOR)

The Mask Option Register is an 8-bit user programmed (EPROM) register in which six of the bits are used. Bits in this register are used to select the type of system clock, the timer option, the timer/prescaler clock source, and the prescaler option. It is fully described in the MASK OPTIONS section.

INTERRUPTS

The MC68705P3 MCU can be interrupted three different ways through the external interrupt ($\overline{\text{INT}}$) input pin, the internal timer interrupt request, or the software interrupt instruction (SWI). When any interrupt occurs the current instruction (including SWI) is completed, processing is suspended, the present CPU state is pushed onto the stack, the interrupt bit (II) in the Condition Code Register is set, the address of the interrupt routine is obtained from the appropriate interrupt vector address, and the interrupt routine is executed Stacking the CPU registers, setting the I-bit, and vector fetching requires a total of 11 toyo periods for completion. A flowchart of the interrupt sequence is shown in

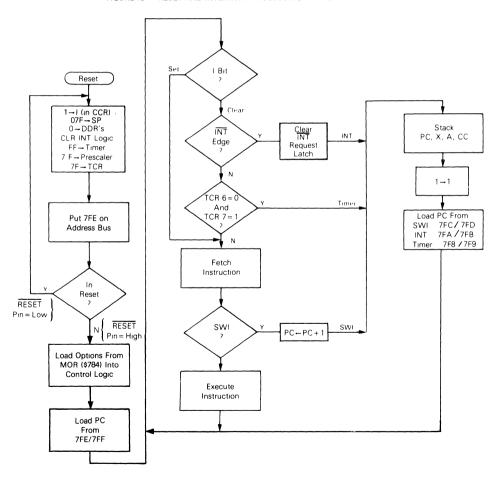
Figure 15 The interrupt service routine must end with a return from interrupt (RTI) instruction which allows the CPU to resume processing of the program prior to the interrupt (by unstacking the previous CPU state). Table 1 provides a listing of the interrupts, their priority, and the address of the vector which contains the starting address of the appropriate interrupt service routine. The interrupt priority, applies to those pending when the CPU is ready to accept a new interrupt (RESET is listed in Table 1 because it is treated as an interrupt. However, it is not normally used as an interrupt i) When the interrupt mask bit in the Condition Code Register is set, the interrupt is latched for later interrupt execution.

TABLE 1 - INTERRUPT PRIORITIES

| Interrupt | Priority | Vector Address |
|-----------|----------|-----------------|
| RESET | 1 | \$7FE and \$7FF |
| SWI | 2* | \$7FC and \$7FD |
| ĪNT | 3 | \$7FA and \$7FB |
| TIMER | 4 | \$7F8 and \$7F9 |

* Priority 2 applies only when the I-bit in the Condition Code Register is set (as when a service routine is occurring). When I = 0 and all interrupts are being accepted, SWI has a priority of 4 (like any other instruction). The priority of INT thus becomes 2 and the timer becomes 3.

FIGURE 15 - RESET AND INTERRUPT PROCESSING FLOWCHART



The external interrupt is internally synchronized and then latched on the falling edge of $\overline{\text{INT}}$ A sinusoidal input signal (f_{|NT} maximum) can be used to generate an external interrupt, as shown in Figure 16a, for use as a Zero-Crossing Detector This allows applications such as servicing time-of-day routines and engaging/disengaging AC power control devices. Off-chip full-wave rectification provides an interrupt at every zero crossing of the AC signal and thereby provides a 2f clock. For digital applications, the $\overline{\text{INT}}$ pin can be driven by a digital signal at a maximum period of twL as shown in Figure 16b

A software interrupt (SWI) is an executable instruction which is executed regardless of the state of the I-bit in the Condition Code Register SWI's are usually used as breakpoints for debugging or as system calls

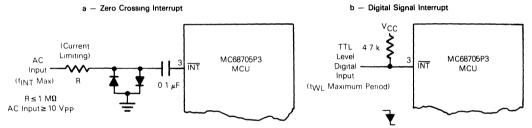
INPUT/OUTPUT

There are 20 input/output pins. (The INT pin may be polled with branch instructions to provide an additional input

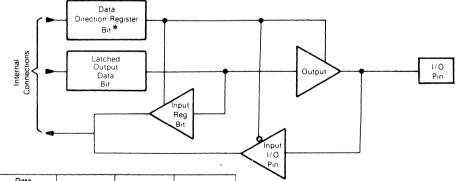
pin) All pins on (Ports A, B, and C) are programmable as either inputs or outputs under software control of the corresponding Data Direction Register (DDR) The port I/O programming is accomplished by writing the corresponding bit in the port DDR to a logic "1" for output or a logic "0" for input On Reset all the DDRs are initialized to a logic "0" state, placing the ports in the input mode. The port output registers are not initialized on Reset but may be written to before setting the DDR bits to avoid undefined levels. When programmed as outputs, the latched output data is readable as input data regardless of the logic levels at the output pin due to output loading, see Figure 17. When Port B is programmed for outputs, it is capable of sinking 10 mA and sourcing 1.0 mA on each pin

All input/output lines are TTL compatible as both inputs and outputs. Port A lines are CMOS compatible as outputs while port B and C lines are CMOS compatible as inputs. The memory map in Figure 6 gives the address of data registers.

FIGURE 16 - TYPICAL INTERRUPT CIRCUITS







| Data Direction Register Bit | Output Data Bit | Output State | Input To MCU |
|-----------------------------|-----------------------|-----------------|--------------------|
| 1 | 0 | 0 | 0 |
| 1 | 1 | 1 | 1 |
| 0 | X | 3 State** | Pin |

- *DDR is a write-only register and reads as all 1's
- **Ports A (with CMOS drive disabled), B, and C are three state ports. Port A has optional internal pullup devices to provide CMOS drive capability. See Electrical Characteristics tables for complete information.

1

and DDRs. The Register configuration is provided in Figure 18. Figure 19 provides some examples of port connections

that all DDR bits in a port must be written using a single-store instruction

Caution

The corresponding DDRs for ports A, B, and C are write-only registers (registers at \$004, \$005, and \$006) A read operation on these registers is undefined Since BSET and BCLR are read/modify/write functions they cannot be used to set or clear a single DDR bit (all "unaffected" bits would be set) It is recommended

The latched output data bit (see Figure 17) may always be written. Therefore, any write to a port writes all of its data bits even though the port DDR is set to input. This may be used to initialize the data registers and avoid undefined outputs, however, care must be exercised when using read/modify/write instructions since the data read corresponds to the pin level if the DDR is an input (0) and corresponds to the latched output data when the DDR is an output (1)

FIGURE 18 - MCU REGISTER CONFIGURATION

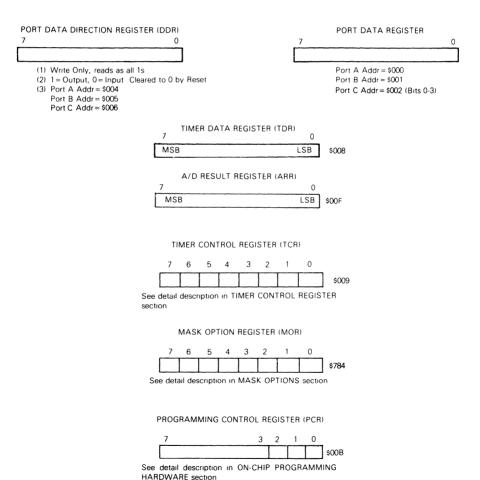
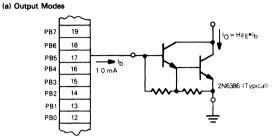


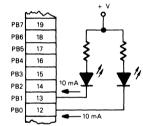
FIGURE 19 - TYPICAL PORT CONNECTIONS

(CMOS Loads) PA7 27 26 PA5 25 PA4 24 (1 TTL Load) 1 6 mA PA3 23 PA2 22 PA1 21 PAO 20

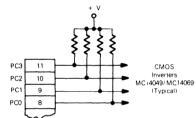
Port A, Bit 7 Programmed as Output, Driving CMOS Loads and Bit 4 Driving one TTL Load Directly



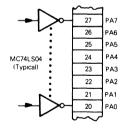
Port B, Bit 5 Programmed as Output, Driving Darlington-Base Directly



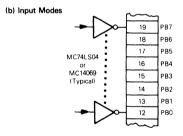
Port B, Bit 0 and Bit 1 Programmed as Output, Driving LEDs Directly



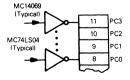
Port C, Bits 0-3 Programmed as Output, Driving CMOS Loads, Using External Pullup Resistors



TTL Driving Port A Directly



CMOS or TTL Driving Port B Directly



CMOS and TTL Driving Port C Directly

TIMER CONTROL REGISTER (TCR)

The configuration of the TCR is determined by the logic level of bit 6 (Timer Option, TOPT) in the Mask Option Register (MOR). Two configurations of the TCR are shown below, one for TOPT=1 and the other for TOPT=0 TOPT=1 configures the TCR to emulate the MC6805P2 or MC6805P4. When TPOT=0, it provides software control of the TCR. When TOPT=1, the prescaler "mask" options are user programmable via the MOR. A description of each TCR bit is provided below (also see Figure 9 and TIMER section)

| b7 | b6 | b5 | b4 | b3 | b2 | b1 | b0 | |
|-----|-----|----|----|----|----|----|----|---------------------------------|
| TIR | TIM | 1 | 1 | 1 | 1 | 1 | 1 | Timer Control Register \$009 |

TCR with MOR TOPT = 1 (MC6805P2/P4 Emulation)

| | | - | | b3 | | | | |
|---------------------------------|-----|-----|-----|------|-----|-----|-----|-----|
| Timer Control Register \$009 | PS0 | PS1 | PS2 | PSC* | TIE | TIN | TIM | TIR |

TCR with MOR TOPT = 0 (Software Programmable Timer)

- b7, TIR Timer Interrupt Request—Used to initiate the timer interrupt or signal a timer Data Register underflow when it is a logical "1"
 - 1 = Set when the Timer Data Register changes to all zeros.
 - 0 = Cleared by external reset or under program control
- b6, TIM Timer Interrupt Mask—Used to inhibit the timer interrupt, to the processor, when it is a logical "1"
 - 1 = Set by an external reset or under program control
 - 0 = Cleared under program control
- b5, TIN External or Internal Selects the input clock source to be either the external TIMER pin (7) or the internal φ2.
 - 1 = Selects the external clock source 0 = Selects the internal $\phi 2$ (fosc $\div 4$) clock source

- b4. TIE External Enable Used to enable the external TIMER pin (7) or to enable the internal clock (if TIN=0) regardless of the external timer pin state (disables gated clock feature) When TOPT=1. TIE is always a logical "1"
 - 1 = Enables external timer pin 0 = Disables external timer pin

TIN-TIE Modes

| TIN | , TIE | CLOCK |
|-----|-------|-----------------------------|
| 0 | 0 | Internal Clock (#2) |
| 0 | 1 | Gated (AND) of External and |
| | | Internal Clocks |
| 1 | 0 | No Clock |
| 1 | 1 | External Clock |

- b3, PSC Prescaler Clear This is a write-only bit. It reads as a logical zero (when TOPT=0) so the BSET and BCLR on the TCR function correctly Writing a 1 into PSC generates a pulse which clears the prescaler (When TOPT=1 this bit is always a logical "1" and has no effect on the prescaler.)
- b2, PS2 Prescaler Select—These bits are decoded to select one of eight taps on the timer prescaler
- b0, PS0 The table shows the prescaler division resulting from decoding these bits

| PS2 | PS1 | PS0 | Prescaler Division |
|--------------------------------------|----------------------------|----------------------------|--|
| 0 0 0 0 1 1 1 1 | 0 0 1 1 0 0 | 0 1 0 1 0 1 | 1 (Bypass Prescaler) 2 4 8 16 32 64 128 |

Note

When changing the PS2-0 bits in software, the PSC bit should be written to a "1" in the same write cycle to clear the prescaler Changing the PS bits without clearing the prescaler may cause an extraneous toggle of the Timer Data Register.

^{* =} write only, reads as a zero

MASK OPTIONS

The MC68705R3 Mask Option Register is implemented in EPROM. Like all other EPROM bytes, the MOR contains all zeros prior to programming

When used to emulate the MC6805P2 or MC6805P4, five of the eight MOR bits are used in conjunction with the prescaler Of the remaining, the b7 bit is used to select the type of oscillator clock, and bits b3 and b4 are not used. Bits b0, b1, and b2 determine the division of the Timer prescaler Bit b5 determines the Timer clock source. The value of the TOPT bit (b6) is programmed to configure the TCR (a logic "1" for MC6805P2/P4 emulation)

If the MOR Timer Option (TOPT) bit is a 0, bits b5, b4, b2, b1, and b0 set the initial value of their respective TCP bits during reset After initialization the TCR is software controllable

A description of the MOR bits is as follows.

| | | b5 | | | | | Mask Option |
|-----|------|-----|------|----|----|----|----------------|
| CLK | TOPT | CLS | | P2 | P1 | P0 | Register \$784 |

b7. CLK Clock Oscillator Type

1 = RC

0 = Crystal

NOTE

VINTP on the TIMER/BOOT pin (7) forces the crystal mode

b6. TOPT Timer Option

1 = MC6805P2/P4 type timer/prescaler. All bits, except 6 and 7, of the Timer-Control Register (TCR) are invisible to the user Bits 5 2, 1, and 0 of the Mask Option Register determine the equivalent MC6805P2/P4 mask options

0= All TCR bits are implemented as a Software Programmable Timer The state of MOR bits 5, 4, 2, 1, and 0 sets the initial values of their respective TCR bits (TCR is then software controlled after initialization)

Timer/Prescaler Clock Source b5, CLS

1 = External TIMER pin

0=Internal \(\phi 2

h4 Not used if MOR TOPT=1 (MC6805P2/P4 emulation) Sets initial value of TCR TIE if MOR TOPT = 0

b3 Not used.

b2. P2 Prescaler Option - the logical levels of these b1, P1 bits, when decoded, select one of eight taps on b0. P0 the timer prescaler. The table below shows the

division resulting from decoding combinations

of these three bits

| P2 | P1 | P0 | Prescaler Division |
|----|----|----|----------------------|
| 0 | 0 | 0 | 1 (Bypass Prescaler) |
| 0 | 0 | 1 | 2 |
| 0 | 1 | 0 | 4 |
| 0 | 1 | 1 | 8 |
| 1 | 0 | 0 | 16 |
| 1 | 0 | 1 | 32 |
| 1 | 1 | 0 | 64 |
| 1 | 1 | 1 | 128 |

Two examples for programming the MOR are discussed below

Example 1 To emulate an MC6805P2 to verfiy your program with an RC oscillator, and an event count input for the timer with no prescaling, the MOR would be set to "11111000" To write the MOR, it is simply programmed as any other EPROM byte

Example 2 Suppose you wish to use the MC68705P3 programmable prescaler functions, and you wish the initial condition of the prescaler to be divided by 64, with the input disabled and an internal clock source. If the clock oscillator was to be in the crystal mode, the MOR would be set to "00001110"

ON-CHIP PROGRAMMING HARDWARE

The Programming Control Register (PCR) at location \$00B is an 8-bit register which utilizes the three LSBs (the five MSBs are set to logic "1s") This register provides the necessary control bits to allow programming the MC68705P3 EPROM The bootstrap program manipulates the PCR when programming so that users need not be concerned with the PCR in most applications. A description of each bit follows.

| b7 | b6 | b5 | b4 | b3 | b2 | b1 | ь0 | Programming |
|----|----|----|----|----|------|-----|-----|----------------|
| 1 | 1 | 1 | 1 | 1 | VPON | PGE | PLE | Control |
| | | | | | | | | Register \$00B |

b0. PLE Programming Latch Enable - When cleared this bit allows the address and data to be latched into the EPROM. When this bit is set, data can be read from the EPROM

1= (set) read EPROM

0=(clear) latch address and data into EPROM (read disabled)

PLE is set during a Reset, but may be cleared any time However, its effect on the EPROM is inhibited if VPON is a logic "1"

b1, PGE Program Enable - When cleared, PGE enables programming of the EPROM PGE can only be cleared if PLE is cleared PGE must be set when changing the address and data, i.e., setting up the byte to be programmed

1 = (set) inhibit EPROM programming

0=(clear) enable EPROM programming (if PLE is low)

PGE is set during a Reset, however, it has no effect on EPROM circuits if VPON is a logic

b2, VPON (Vpp ON) - VPON is a read-only bit and when at a logic "0" it indicates that a "high voltage" is present at the Vpp pin

1 = no "high voltage" on Vpp pin

0= "high voltage" on Vpp pin

VPON being "1" "disconnects" PGE and PLE from the rest of the chip, preventing accidental clearing of these bits from effecting the normal operating mode

Note

VPON being "0" does not indicate that the Vpp level is correct for programming. It is used as a safety interlock for the user in the normal operating mode

| VPON | PGE | PLE | Programming Conditions |
|------|-----|-----|---|
| 0 | 0 | 0 | Programming mode (program EPROM byte) |
| 1 | 0 | 0 | PGE and PLE disabled from system |
| 0 | 1 | 0 | Programming disabled (latch address and |
| | | | data in EPROM) |
| 1 | 1 | 0 | PGE and PLE disabled from system |
| 0 | 0 | 1 , | Invalid state, PGE = 0 iff PLE = 0 |
| 1 | 0 | 1 | Invalid state, PGE=0 iff PLE=0 |
| 0 | 1 | 1 | "High voltage" on Vpp |
| 1 | 1 | 1 | PGE and PLE disabled from system |
| | | | (Operating Mode) |
| 1 | | | |

ERASING THE EPROM

The MC68705P3 EPROM can be erased by exposure to high-intensity ultraviolet (UV) light with a wavelength of

2537 Å The recommended integrated dose (UV intensity x exposure time) is 15 Ws/cm². The lamps should be used without shortwave filters and the MC68705P3 should be positioned about one inch from the UV tubes. Ultraviolet erasure clears all bits of the MC68705P3 EPROM to the "0" state. Data is then entered by programming "1s" into the desired bit locations.

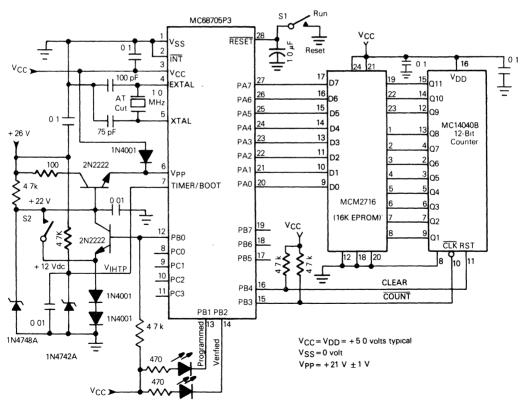
Caution

Be sure that the EPROM window is shielded from light except when erasing. This protects both the EPROM and light-sensitive nodes.

PROGRAMMING FIRMWARE

The MC68705P3 has 115 bytes of mask ROM containing a bootstrap program which can be used to program the MC68705P3 EPROM. The vector at addresses \$7F6 and \$7F7 is used to start executing the program. This vector is fetched when VIHTP is applied to pin 7 (TIMER/BOOT pin) of the MC68705P3 and the $\overline{\rm RESET}$ pin is allowed to rise above VIRES +. Figure 20 provides a schematic diagram of a circuit and a summary of programming steps which can be used to program the EPROM in the MC68705P3

FIGURE 20 - PROGRAMMING CONNECTIONS SCHEMATIC DIAGRAM



Summary of Programming Steps

- 1 When plugging in the MC68705P3 or the MCM2716, be sure that S1 and S2 are closed and that V_{CC} and + 26 V are not applied
- 2 To initiate programming, be sure S1 is closed, S2 is closed, and V_{CC} and +26 V are applied. Then open S2, followed by S1
- 3 Before removing the MC68705P3, first close S2 and then close S1 Disconnect V_{CC} and +26 V, then remove the MC68705P3

PROGRAMMING STEPS

The MCM2716 UV EPROM must first be programmed with an exact duplicate of the information that is to be transferred to the MC68705P3. Non-EPROM addresses are ignored by the bootstrap. Since the MC68705P3 and the MCM2716 are to be inserted and removed from the circuit they should be mounted in sockets. In addition, the precaution below must be observed (refer to Figure 20):

Caution

Be sure S1 and S2 are closed and V_{CC} and +26 V are not applied when inserting the MC68705P3 and MCM2716 into their respective sockets. This ensures that RESET is held low while inserting the devices

When ready to program the MC68705P3 it is only necessary to provide V $_{CC}$ and +26 V, open switch S2 (to apply Vpp and V $_{IHTP}$), and then open S1 (to remove Reset) Once the voltages are applied and both S2 and S1 are open, the CLEAR output control line (PB4) is clocked by the PB3 output (\overline{COUNT}). The counter selects the MCM2716 EPROM byte which is to load the equivalent MC68705P3 EPROM location is loaded, \overline{COUNT} clocks the counter to the next EPROM location. This continues until the MC68705P3 is completely programmed at which time the Programmed indicator LED is litt. The counter is cleared and the loop is repeated to verify the programmed data. The Verified indicator LED lights if the programming is correct

Once the MC68705P3 has been programmed and verified, close switch S2 (to remove Vpp and ViHTP) and close switch S1 (to Reset) Disconnect +26 V and V_{CC}, then remove the MC68705P3 from its socket

MC6805P2 EMULATION

The MC68705P3 emulates the MC6805P2, the Mask Option Register (MOR), the MC6805P2 and MC6805P4 "exactly." MC6805P2/P4 mask feature, are implemented in (MOR) EPROM byte on the MC68705P3. There are a few minor exceptions to the exactness of emulation which are listed below

- 1 The MC6805P2 "future ROM" area is implemented in the MC68705P3 and these 704 bytes must be left unprogrammed to accurately simulate the MC6805P2/P4 (The MC6805P2/P4 reads all zeros from this area.)
- The reserved ROM areas in the MC6805P2/P4 and MC68705P3 have different data stored in them and this data is subject to change without notice. The

- MC6805P2 uses the reserved ROM for the self-check feature and the MC68705P3 uses this area for the bootstrap program.
- 3 The MC6805P2 reads all ones in its 48 byte "future RAM" area. This RAM is not implemented in the MC6805P2 mask ROM version, but is implemented in the MC68705P3 and MC68705P4.
- 4 The Vpp line (pin 6) in the MC68705P3 must be tied to V_{CC} for normal operation. In the MC6805P2, pin 6 is the NUM pin and is grounded in normal operation. The MC6805P4 uses pin 6 for V_{SS} which is normally tied to V_{CC}, as with the MC68705P4.
- 5 The LVI feature is not available in the MC68705P3 Processing differences are not presently compatible with proper design of this feature in the EPROM version
- 6 The function in the Non-User Mode is not identical to the MC6805P2/P4 version. Therefore, the MC68705P3 does not function in the MEX6805 Support System. In normal operation, all pin functions are the same as on the MC6805P2/P4 version, except for pin 6 as previously noted.
- The MC6805P4 provides a standby RAM feature which is not available on the MC68705P3

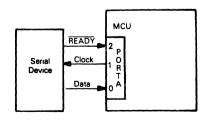
The operation of all other circuitry has been exactly duplicated or designed to function exactly the same in both devices including Interrupts, Timer, Data Ports, and Data Direction Registers (DDRs). A stated design goal has been to provide the user with a safe inexpensive way to verify his program and system design before committing to a factory programmed ROM.

SOFTWARE

BIT MANIPULATION

The MC68705P3 MCU has the ability to set or clear any single random-access memory or input/output bit (except the Data Direction Register, see Caution under INPUT/OUT-PUT paragraph), with a single instruction (BSET, BCLR) Any bit in the page zero memory can be tested, using the BRSET and BRCLR instructions and the program branches as a result of its state. The Carry bit equals the value of the bit referenced by BRSET and BRCLR. A Rotate instruction may then be used to accumulate serial input data in a RAM location or register. This capability to work with any bit in RAM, ROM, or I/O allows the user to have individual flags in RAM or to handle I/O bits as control lines. The coding example in Figure 21 illustrates the usefulness of the bit manipulation and test instructions. Assume that the MCU is to communicate with an external serial device.

FIGURE 21 — BIT MANIPULATION EXAMPLE



SELF BRSET 2, PORTA, SELF

BSET 1, PORTA
BRCLR 0, PORTA, CONT
CONT BCLR 1, PORTA
ASR RAMLOC

has a data ready signal, a data output line, and a clock line to clock data one bit at a time, LSB first, out of the device. The MCU waits until the data is ready, clocks the external device, picks up the data in the Carry flag (C-bit), clears the clock line, and finally accumulates the data bit in a RAM location.

ADDRESSING MODES

The MC68705P3 MCU has 10 addressing modes which are explained briefly in the following paragraphs. For additional details and graphical illustrations, refer to the M6805 Family Users Manual.

The term "effective address" (EA) is used in describing the addressing modes EA is defined as the address from which the argument for an instruction is fetched or stored

IMMEDIATE — In the immediate addressing mode, the operand is contained in the byte immediately following the opcode. The immediate addressing mode is used to access constants which do not change during program execution (e.g., a constant used to initialize a loop counter).

DIRECT — In the direct addressing mode, the effective address of the argument is contained in a single byte following the opcode byte Direct addressing allows the user to directly address the lowest 256 bytes in memory with a single 2-byte instruction. This address area includes all on-chip RAM, I/O registers, and 128 bytes of EPROM. Direct addressing is an effective use of both memory and time.

EXTENDED — In the extended addressing mode, the effective address of the argument is contained in the two bytes following the opcode Instructions using extended addressing are capable of referencing arguments anywhere in memory with a single 3-byte instruction. When using the Motorola assembler, the programmer need not specify whether an instruction uses direct or extended addressing. The assembler automatically selects the shortest form of the instruction.

RELATIVE — The relative addressing mode is only used in branch instructions. In relative addressing, the contents of the 8-bit signed byte following the opcode (the offset) is added to the PC, if and only if, the branch condition is true. Otherwise, control proceeds to the next instruction. The span of relative addressing is from $-126\ {\rm to}+129\ {\rm from}$ the opcode address. The programmer need not worry about calculting the correct offset when using the Motorola assembler, since it calculates the proper offset and checks to see if it is within the span of the branch

INDEXED, NO OFFSET — In the indexed, no offset addressing mode, the effective address of the argument is contained in the 8-bit index register. Thus, this addressing mode can access the first 256 memory locations. These instructions are only one byte long. This mode is often used to move a pointer through a table or to hold the address of a frequency referenced RAM or I/O location.

INDEXED, 8-BIT OFFSET — In the indexed, 8-bit offset addressing mode, the effective address is the sum of the contents of the unsigned 8-bit index register and unsigned byte following the opcode. This addressing mode is useful in selecting the kth element in an n element table. With this 2-byte instruction, k would typically be in X with the address of the beginning of the table in the instruction. As such tables may begin anywhere within the first 256 addressable locations and could extend as far as location 511 (\$1FE).

INDEXED, 16-BIT OFFSET — In the indexed, 16-bit offset addressing mode, the effective address is the sum of the contents of the unsigned 8-bit index register and the two unsigned bytes following the opcode. This address mode can be used in a manner similar to indexed, 8-bit offset, except that this 3-byte instruction allows tables to be anywhere in memory. As with Direct and Extended addressing, the Motorola assembler determines the shortest form of indexed addressing.

BIT SET/CLEAR — In the bit set/clear addressing mode, the bit to be set or cleared is part of the opcode and the byte following the opcode specifies the direct address of the byte in which the specified bit is to be set or cleared Thus, any read/write bit in the first 256 locations of memory, including I/O, can be selectively set or cleared with a single 2-byte instruction. See Caution under the INPUT/OUTPUT paragraph.

BIT TEST AND BRANCH — The bit test and branch addressing mode is a combination of direct addressing and relative addressing. The bit which is to be tested and the condition (set or clear) is included in the opcode, and the address of the byte to be tested is in the single byte immediately following the opcode byte. The signed relative 8-bit offset is in the third byte and is added to the value of the PC, if the branch condition is true. This single 3-byte instruction allows the program to branch based on the condition of any readable bit in the first 256 locations of memory. The span of branching is from —125 to +130 from the opcode address. The state of the tested bit is also transferred to the Carry bit of the Condition Code Register. See Caution under the INPUT/OUTPUT paragraph.

INHERENT — In the inherent addressing mode, all the information necessary to execute the instruction is contained in the opcode. Operations specifying only the index register or accumulator, as well as control instruction with no other arguments, are included in this mode. These instructions are one byte long.

INSTRUCTION SET

The MC68705P3 MCU has a set of 59 basic instructions, which when combined with the 10 addressing modes produce 207 usable opcodes. One operand is either the accumulator or the index register. The other operand is obtained from memory using one of the addressing modes. The jump unconditional (JMP) and jump to subroutine (JSR) instructions have no register operand. Refer to Table 2.

READ/MODIFY/WRITE INSTRUCTIONS — These instructions read a memory location or a register, modify or test its contents, and write the modified value back to memory or to the register (see Caution under INPUT/OUT-PUT paragraph) The test for negative or zero (TST) instruction is included in the read/modify/write instructions, though it does not perform the write. Refer to Table 3

BRANCH INSTRUCTIONS — The branch instructions cause a branch from the program when a certain condition is met. Refer to Table 4

BIT MANIPULATION INSTRUCTIONS — These instructions are used on any bit in the first 256 bytes of the memory

(see Caution under INPUT/OUTPUT paragraph) One group either sets or clears. The other group performs the bit and test branch operations. Refer to Table 5.

 $\begin{array}{cccc} \textbf{CONTROL INSTRUCTIONS} & -\text{The control instructions} \\ \text{control the MCU operations during program execution} \\ \text{Refer to Table 6} \end{array}$

ALPHABETICAL LISTING — The complete instruction set is given in alphabetical order in Table 7

 $\mbox{OPCODE MAP SUMMARY}-\mbox{Table 8}$ is an opcode map for the instructions used on the MCU

TABLE 2 - REGISTER/MEMORY INSTRUCTIONS

| | | | Addressing Modes | | | | | | | | | | | | | | | | |
|---|----------|------------|--|-------------|------------|------------|-------------|------------|------------|-------------|------------|------------|-------------|------------|------------|-------------|------------|------------|-------------|
| | | | Immediate Direct Extended (No Offset) (8-Bit Offset) (16-Bit Offset) | | | | | | | | | | | | | | | | |
| Function | Mnemonic | Op Code | # Bytes | # Cycles | Op Code | # Bytes | # Cycles | Op Code | # Bytes | # Cycles | Op Code | # Bytes | # Cycles | Op Code | # Bytes | # Cycles | OP Code | # Bytes | # Cycles |
| Load A from Memory | LDA | A6 | 2 | 2 | В6 | 2 | 4 | C6 | 3 | 5 | F6 | 1 | 4 | E6 | 2 | 5 | D6 | 3 | 6 |
| Load X from Memory | LDX | AE | 2 | 2 | BE | 2 | 4 | CE | 3 | 5 | FE | 1 | 4 | EE | 2 | 5 | DE | 3 | 6 |
| Store A in Memory | STA | - | - | | B7 | 2 | 5 | C7 | 3 | 6 | F7 | 1 | 5 | E7 | 2 | 6 | 07 | 3 | 7 |
| Store X in Memory | STX | - | - I | _ | BF | 2 | 5 | CF | 3 | 6 | FF | 1 | 5 | EF | 2 | 6 | DF | 3 | 7 |
| Add Memory to A | ADD | AB | 2 | 2 | BB | 2 | 4 | CB | 3 | 5 | FB | 1 | 4 | ĿВ | 2 | 5 | DB | 3 | 6 |
| Add Memory and Carry to A | ADC | А9 | 2 | 2 | В9 | 2 | 4 | С9 | 3 | 5 | F9 | 1 | 4 | E9 | 2 | 5 | D9 | 3 | 6 |
| Subtract Memory | SUB | A0 | 2 | 2 | В0 | 2 | 4 | CO | 3 | 5 | F0 | 1 | 4 | EO | 2 | 5 | D0 | 3 | 6 |
| Subtract Memory from A with Borrow | SBC | A2 | 2 | 2 | В2 | 2 | 4 | C2 | 3 | 5 | F2 | 1 | 4 | E2 | 2 | 5 | D2 | 3 | 6 |
| AND Memory to A | AND | Α4 | 2 | 2 | 84 | 2 | 4 | C4 | 3 | 5 | F4 | 1 | 4 | E4 | 2 | 5 | D4 | 3 | 6 |
| OR Memory with A | ORA | AA | 2 | 2 | BA | 2 | 4 | CA | 3 | 5 | FA | 1 | 4 | EA | 2 | 5 | DA | 3 | 6 |
| Exclusive OR Memory with A | EOR | A8 | 2 | 2 | в8 | 2 | 4 | C8 | 3 | 5 | F8 | 1 | 4 | E8 | 2 | 5 | D8 | 3 | 6 |
| Arithmetic Compare A with Memory | СМР | Α1 | 2 | 2 | В1 | 2 | 4 | C1 | 3 | 5 | F1 | 1 | 4 | E1 | 2 | 5 | D1 | 3 | 6 |
| Arithmetic Compare X with Memory | СРХ | А3 | 2 | 2 | в3 | 2 | 4 | сз | 3 | 5 | F3 | 1 | 4 | E3 | 2 | 5 | D3 | 3 | 6 |
| Bit Test Memory with A (Logical Compare) | ВІТ | A5 | 2 | 2 | B 5 | 2 | 4 | C5 | 3 | 5 | F5 | 1 | 4 | E5 | 2 | 5 | D5 | 3 | 6 |
| Jump Unconditional | JMP | - | - | - | BC | 2 | 3 | CC | 3 | 4 | FC | 1 | 3 | EC | 2 | 4 | DC | 3 | 5 |
| Jump to Subroutine | JSR | - | - | | BD | 2 | 7 | CD | 3 | 8 | FD | 1 | 7 | ED | 2 | 8 | DD | 3 | 9 |

TABLE 3 - READ/MODIFY/WRITE INSTRUCTION

| | | | Addressing Modes | | | | | | | | | | | | | | | |
|------------------------------|----------|------------|---------------------|-------------|------------|--------------------------------|---|------------|------------|-------------|----|---|-------------|------------|---------------------------|-------------|--|--|
| | | | Indexed (No Offset) | | | | | | | | | | | (8 | Indexed (8 Bit Offset) | | | |
| Function | Mnemonic | Op Code | # Bytes | # Cycles | Op Code | Op # # (Code Bytes Cycles Code | | Op Code | # Bytes | # Cycles | | | # Cycles | Op Code | # Bytes | # Cycles | | |
| Increment | INC | 4C | 1 | 4 | 5C | 1 | 4 | 3C | 2 | 6 | 7C | 1 | 6 | 6C | 2 | 7 | | |
| Decrement | DEC | 4A | 1 | 4 | 5A | 1 | 4 | 3A | 2 | 6 | 7A | 1 | 6 | 6A | 2 | 7 | | |
| Clear | CLR | 4F | 1 | 4 | 5F | 1 | 4 | 3F | 2 | 6 | 7F | 1 | 6 | 6F | 2 | 7 | | |
| Complement | сом | 43 | 1 | 4 | 53 | 1 | 4 | 33 | 2 | 6 | 73 | 1 | 6 | 63 | 2 | 7 | | |
| Negate (2's Complement) | NEG | 40 | 1 | 4 | 50 | 1 | 4 | 30 | 2 | 6 | 70 | 1 | 6 | 60 | 2 | 7 | | |
| Rotate Left Thru Carry | ROL | 49 | 1 | 4 | 59 | 1 | 4 | 39 | 2 | 6 | 79 | 1 | 6 | 69 | 2 | 7 | | |
| Rotate Right Thru Carry | ROR | 46 | 1 | 4 | 56 | 1 | 4 | 36 | 2 | 6 | 76 | 1 | 6 | 66 | 2 | 7 | | |
| Logical Shift Left | LSL | 48 | 1 | 4 | 58 | 1 | 4 | 38 | 2 | 6 | 78 | 1 | 6 | 68 | 2 | 7 | | |
| Logical Shift Right | LSR | 44 | 1 | 4 | 54 | 1 | 4 | 34 | 2 | 6 | 74 | 1 | 6 | 64 | 2 | 7 | | |
| Arithmetic Shift Right | ASR | 47 | 1 | 4 | 57 | 1 | 4 | 37 | 2 | 6 | 77 | 1 | 6 | 67 | 2 | 7 | | |
| Test for Negative or Zero | TST | 4D | 1 | 4 | 5D | 1 | 4 | 3D | 2 | 6 | 7D | 1 | 6 | 6D | 2 | 7 | | |

TABLE 4 - BRANCH INSTRUCTIONS

| | | Rela | tive Addres | sing Mode |
|--|----------|------------|-------------|-----------|
| Function | Mnemonic | Op Code | # Bytes | Cycles |
| Branch Always | BRA | 20 | 2 | 4 |
| Branch Never | BRN | 21 | 2 | 4 |
| Branch IFF Higher | ВНІ | 22 | 2 | 4 |
| Branch IFF Lower or Same | BLS | 23 | 2 | 4 |
| Branch IFF Carry Clear | BCC | 24 | 2 | 4 |
| (Branch IFF Higher or Same) | (BHS) | 24 | 2 | 4 |
| Branch IFF Carry Set | BCS | 25 | 2 | 4 |
| (Branch IFF Lower) | (BLO) | 25 | 2 | 4 |
| Branch IFF Not Equal | BNE | 26 | 2 | 4 |
| Branch IFF Equal | BEQ | 27 | 2 | 4 |
| Branch IFF Half Carry Clear | внсс | 28 | 2 | 4 |
| Branch IFF Half Carry Set | BHCS | 29 | 2 | 4 |
| Branch IFF Plus | BPL | 2A | 2 | 4 |
| Branch IFF Minus | ВМІ | 2B | 2 | 4 |
| Branch IFF Interrupt Mask Bit is Clear | BMC | 2C | 2 | 4 |
| Branch IFF Interrupt Mask Bit is Set | BMS | 2D | 2 | 4 |
| Branch IFF Interrupt Line is Low | BIL | 2E | 2 | 4 |
| Branch IFF Interrupt Line is High | ВІН | 2F | 2 | 4 |
| Branch to Subroutine | BSR | AD | 2 | 8 |

TABLE 5 - BIT MANIPULATION INSTRUCTIONS

| | | | Addressing Modes | | | | | | | | | |
|---------------------------|-------------------|------------|------------------|-------------|------------|---------------|-------------|--|--|--|--|--|
| | | E | Bit Set/Clea | 7 | Bi | t Test and Br | anch | | | | | |
| Function | Mnemonic | Op Code | # Bytes | # Cycles | Op Code | # Bytes | # Cycles | | | | | |
| Branch IFF Bit n is set | BRSET n (n = 0 7) | _ | - | | 2 • n | 3 | 10 | | | | | |
| Branch IFF Bit n is clear | BRCLR n (n = 0 7) | _ | - 1 | _ | 01 + 2 • n | 3 | 10 | | | | | |
| Set Bit n | BSET n (n = 0 7) | 10 + 2 • n | 2 | 7 | | _ | _ | | | | | |
| Clear Bit n | BCLR n (n = 0 7) | 11 + 2 • n | 2 | 7 | - | | - | | | | | |

TABLE 6 - CONTROL INSTRUCTIONS

| | | | Inhere | nt |
|--------------------------|----------|------------|------------|-------------|
| Function | Mnemonic | Op Code | # Bytes | # Cycles |
| Transfer A to X | TAX | 97 | 1 | 2 |
| Transfer X to A | TXA | 9F | 1 | 2 |
| Set Carry Bit | SEC | 99 | 1 | 2 |
| Clear Carry Bit | CLC | 98 | 1 | 2 |
| Set Interrupt Mask Bit | SEI | 9B | 1 | 2 |
| Clear Interrupt Mask Bit | CLI | 9A | 1 | 2 |
| Software Interrupt | SWI | 83 | 1 | 11 |
| Return from Subroutine | RTS | 81 | 1 | 6 |
| Return from Interrupt | RTI | 80 | 1 | 9 |
| Reset Stack Pointer | RSP | 9C | 1 | 2 |
| No-Operation | NOP | 9D | 1 | 2 |

TABLE 7 - INSTRUCTION SET

| | | | | | Addressin | g Modes | | | | | Co | ndit | tion | Co | des |
|----------|----------|-----------|--------|----------|-----------|------------------------|---------------------|----------------------|----------------------|-------------------------|----|------|------|----|-----|
| Mnemonic | Inherent | Immediate | Direct | Extended | Relative | Indexed (No Offset) | Indexed (8 Bits) | Indexed (16 Bits) | Bit Set/ Clear | Bit Test & Branch | н | ı | N | z | С |
| ADC | | Х | X | X | | X | X | X | | | Λ | • | Λ | Λ | Λ |
| ADD | | X | Х | X | | × | × | × | | | Λ | • | Λ | Λ | Λ |
| AND | | X | X | X | | Х | X | X | | | • | • | Λ | Λ | • |
| ASL | X | | X | | | X | X | | i | | • | • | Λ | Λ | Λ |
| ASR | X | | X | | | X | X | | | | • | • | Λ | Λ | Λ |
| ВСС | | | | | X | | | | | | • | • | • | • | • |
| BCLR | | | | | | | | | X | | • | • | • | • | • |
| BCS | | | | | X | | | | | | • | • | • | • | • |
| BEQ | | | | | X | | | | | | • | • | • | • | • |
| внсс | | | | | X | | | | | | • | • | • | • | • |
| BHCS | | | | | X | | | | | | • | • | • | • | • |
| ВНІ | | | | | X | | | | | | • | • | • | • | • |
| BHS | | | | | X | | <u> </u> | 1 | | | • | • | • | • | • |
| BIH | | | | | X | | | | | | • | • | • | • | • |
| BIL | | | | | X | | | | | | • | • | • | • | • |
| BIT | | Х | X | X | | X | X | X | | | • | • | Λ | Λ | • |
| BLO | | | | | X | | | | | 1 | • | • | • | • | • |
| BLS | | | | | X | | | | | | • | • | • | • | • |
| ВМС | | | | | X | | | | | | • | • | • | • | • |
| ВМІ | | | | | X | | | | | T | • | • | • | • | • |
| BMS | | | | | X | | | | | | • | • | • | • | • |
| BNE | | | | | X | | | | | | • | • | • | • | • |
| BPL | | | | | X | | | | | | • | • | • | • | • |
| BRA | | | | | Х | | | | | | • | • | • | • | • |
| BRN | | | | | X | | | | | | • | • | • | • | • |
| BRCLR | | | | | | | | | | X | • | • | • | • | Λ |
| BRSET | | | | | | | | | | Х | • | • | • | • | Λ |
| BSET | | | | | | | | | X | | • | • | • | • | • |
| BSR | | | | | X | | l | | | 1 | • | • | • | • | • |
| CLC | X | | | | | | | | | | • | • | • | • | 0 |
| CLI | X | | | | | | | | | | • | 0 | • | • | • |
| CLR | X | | × | | | X | X | | | | • | • | 0 | 1 | • |
| CMP | | Х | X | X | | X | X | X | | | • | • | Λ | Λ | Λ |
| СОМ | X | | × | | | Х | X | | | | • | • | Λ | Λ | 1 |
| CPX | | Х | × | X | | X | X | X | | | • | • | Λ | Λ | Λ |

- Condition Code Symbols H Half Carry (From Bit 3)
- Interrupt Mask
- Negative (Sign Bit)
- Zero
- N Z C Carry/Borrow
- Test and Set if True, Cleared Otherwise
- Not Affected
- Load CC Register From Stack
- Set Clear

TABLE 7 - INSTRUCTION SET (CONTINUED)

| | | | | | Addressin | g Modes | | | | | Co | ndit | ion | Co | des |
|----------|----------|-----------|--------|----------|-----------|------------------------|---------------------|----------------------|----------------------|-------------------------|----|------|-----|----|-----|
| Mnemonic | Inherent | Immediate | Direct | Extended | Relative | Indexed (No Offset) | Indexed (8 Bits) | Indexed (16 Bits) | Bit Set/ Clear | Bit Test & Branch | н | | N | z | С |
| DEC | X | | Х | | | X | X | | | | • | • | Λ | Λ | • |
| EOR | | X | X | X | | X | Х | X | | | • | • | Λ | Λ | • |
| INC | X | | Х | | | X | Х | | | | • | • | Λ | Λ | • |
| JMP | | | Х | X | | Х | Х | Х | | | • | • | • | • | • |
| JSR | | | X | X | | X | Х | X | | | • | • | • | • | • |
| LDA | | X | Х | Х | | X | X | X | | | • | • | Λ | Λ | • |
| LDX | | X | Х | X | | X | X | X | | | • | • | Λ | Λ | • |
| LSL | X | | X | | | X | Х | | | | • | • | Λ | Λ | Λ |
| LSR | X | | X | | | X | Х | | | | • | • | 0 | Λ | Λ |
| NEQ | X | | Х | | | X | Х | | | | • | • | Λ | Λ | Λ |
| NOP | X | | | | | | | | | | • | • | • | • | • |
| ORA | | X | X | Х | | X | Х | Х | | | • | • | Λ | Λ | • |
| ROL | X | | X | | | Х | Х | | | | • | • | Λ | Λ | Λ |
| RSP | X | | | | | | | | | | • | • | • | • | • |
| RTI | X | | | | | | | | | | 7 | ? | 7 | 7 | 7 |
| RTS | × | | | | | | | | | | • | • | • | • | • |
| SBC | | X | X | Х | | Х | Х | X | | | • | • | Λ | Λ | Λ |
| SEC | X | | | | | | | | | | • | • | • | • | 1 |
| SEI | X | | | | | | | | | | • | 1 | • | • | • |
| STA | | | Х | Х | | Х | Х | X | | | • | • | Λ | Λ | • |
| STX | | | Х | Х | | Х | Х | Х | | | • | • | Λ | Λ | • |
| SUB | | X | Х | X | | Х | Х | X | | | • | • | Λ | Λ | Λ |
| SWI | X | | | | | | | | | | • | 1 | • | • | • |
| TAX | X | | | | | | | | | | • | • | • | • | • |
| TST | X | | Х | | | Х | Х | | | | • | • | Λ | Λ | • |
| TXA | X | | | | | | | | | | • | • | • | • | • |

Condition Code Symbols

- Half Carry (From Bit 3)
- Interrupt Mask
- N Z C A Negative (Sign Bit)
- Zero
- Carry/Borrow
- Test and Set if True, Cleared Otherwise
- Not Affected
- Load CC Register From Stack
- Set Clear

TABLE 8 - M6805 FAMILY INSTRUCTION SET OPCODE MAP

| | Bit Manip | ulation | Branch | | Re | ad/Modify/\ | Write | | Con | trol | | | Registe | r/Memory | | | |
|-----------|---------------------------------|-------------------|---------------------|-------------------------|----------------------|----------------------|---------------------|--------------|----------------------|---------------------|---|---------------------|---------------------|---------------------|---------------------|--------------------|-----------|
| | BTB | BSC | REL | DIR | INH(A) | INH(X) | IX1 | IX | INH | INH | IMM | DIR | EXT | IX2 | IX1 | IX. | L |
| Low | 0000 | 0001 | 2 0010 | 3 0011 | 0100 | 5 0101 | 0110 | 0111 | 1000 | 1001 | 1010 | B 1011 | C 1100 | D 1101 | 1110 | 1111 | Hi |
| 0 | 3 BTB 2 | BSETO 5 BSC | 4 BRA 2 REL | | | | 7 NEG 6 2 IX1 | | 9 9 RTI 1 INH | | SUB 2 IMM | SUB DIR | SUB 3 EXT | SUB 3 IX2 | SUB IX1 | SUB | 0000 |
| 1 0001 | 3 BTB 2 | BCLRO 5 BSC | 4 3 BRN 2 REL | | | | | | 6 RTS 1 INH | | CMP 2 IMM | CMP 3 | 5 CMP 3 EXT | 6 CMP 3 IX2 | 5 CMP 2 IX1 | CMP 1X | 1 0001 |
| 2 0010 | 3 BTB 2 | BSET1 5 | BHI REL | | | 4 3 | | 6 5 | 11 10 | | SBC 2 | SBC 3 | SBC 4 3 EXT | SBC 5 | SBC 1x1 | SBC IX | 2 0010 |
| 3 0011 | 10 5 7 BRCLR1 1 3 BTB 2 | BCLR1 BSC | BLS REL | 6 COM 5 2 DIR 6 5 | COMA | COMX | COM 1X1 | 6 COM 5 | SWI 1 INH | | CPX 2 IMM | CPX DIR | CPX EXT | 6 CPX 5 | CPX 1X1 | CPX X | 3 0011 |
| 0100 | | BSET2 BSC | BCC REI | LSR 2 DIR | LSRA | LSRX | LSR 2 IX1 | LSR | | | AND 2 | AND 2 DIR | AND 3 EXT | AND 3 1X2 | AND IX1 | AND | 0100 |
| 5 0101 | | BCLR2 BSC | BCS REL | 6 5 | 4 3 | 4 3 | 7 6 | 6 5 | | | BIT 2 IMM | BIT DIR | BIT 3 EXT | 3 IX2 | BIT XI | BIT | 5 0101 |
| 6 0110 | BRSET3 3 BTB 2 | BSET3 BSC | BNE REL | ROR 2 DIR | RORA INH | RORX 1 INH 4 3 | ROR 2 IX1 | ROR 1 1X | | 2 2 | LDA 2 IMM | LDA 2 DIR | LDA 3 EXT | LDA 3 IX2 | LDA IXI | LDA | 6 0110 |
| 7 0111 | BRCLR3 10 5 7 | BCLR3 BSC | BEQ 2 REL 4 3 | ASR 2 DIR 6 5 | ASRA 1 INH 4 3 | ASRX 1 INH | ASR 2 1X1 7 6 | ASR 1X | | TAX 1 INH 2 2 | 2 2 | STA 2 DIR | STA 3 EXT | STA 3 IX2 | STA IX1 | STA IX | 7 0111 |
| 1000 | BRSET4 1 3 BTB 2 | BSET4 BSC | BHCC REL | LSL 2 DIR 6 5 | LSLA 1 INH | LSLX 1 INH | LSL 2 1×1 7 6 | LSL 1 1X 6 5 | | CLC INH | EOR 2 IMM | EOR DIR | EOR 3 EXT | EOR 3 IX2 | EOR IX1 | EOR | 8 1000 |
| 1001 | BRCLR4 1 3 BTB 2 10 5 7 | BCLR4 BSC | BHCS REL | ROL 2 DIR 6 5 | ROLA 1 INH | ROLX 1 INH | ROL 2 1X1 7 6 | ROL 1 1X 6 5 | | SEC INH | ADC 1MM | ADC DIR | ADC 3 EXT | ADC 1X2 | ADC IX1 | ADC | 9 1001 |
| 1010 | 3 BTB 2 | BSET5 BSC 5 | BPL 2 REL 4 3 | DEC DIR | DECA 1 INH | DECX 1 INH | DEC 1X1 | DEC | | CLI 1 INH 2 2 | ORA 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 | ORA 2 DIR | ORA 3 EXT | ORA 3 1X2 | ORA 2 1X1 | ORA IX | A 1010 |
| B 1011 | BRCLR5 1 3 BTB 2 10 5 7 | BCLR5 BSC 5 | BMI 2 REL 4 3 | 6 5 | 4 3 | 4 3 | | 6 5 | | SEI 1 INH 2 2 | ADD 1 | ADD DIR | ADD 3 EXT 4 3 | ADD 3 1X2 5 4 | ADD 1X1 | ADD IX | B 1011 |
| C 1100 | 3 B1B 2 | BSET6 BSC 5 | BMC REL 4 3 | INC 2 DIR 6 4 | INCA 1 INH 4 3 | INCX 1 INH 4 3 | INC 2 1X1 7 5 | INC | | RSP 1 INH 2 2 | B 6 | JMP 2 DIR 7 5 | JMP 3 EXT 8 6 | JMP 3 1X2 | JMP 2 IX1 8 6 | JMP 1X 7 5 | 1100 |
| D 1101 | 3 BTB 2 | | BMS 2 REL 4 3 | TST 2 DIR | TSTA 1 INH | TSTX 1 INH | TST IX1 | TST | 2 | NOP 1 INH | BSR 2 REL 2 2 | JSR 2 DiR 4 3 | JSR 3 EXT | JSR 3 1x2 5 5 | JSR 2 1X1 5 4 | JSR 1 IX 4 3 | D 1101 |
| 1110 | 3 BTB 2 | BSET7 BSC 5 | BIL 2 REL 4 3 | | | 4 3 | 7 6 | 6 5 | * STOP 1 INH 2 | 2 2 | LDX 2 IMM | | LDX 3 EXT 6 5 | 3 IX2 | LDX 2 1X1 6 5 | LDX 5 4 | 1110 |
| F 1111 | BRCLR7 BTB 2 | BCLR7 BSC | 2 REL | CLR 2 DIR | CLRA 1 INH | CLRX | CLR IX1 | CLR | * WAIT | TXA 1 INH | | STX 2 DIR | STX 3 EXT | STX 3 IX2 | STX 2 IX1 | STX | F 1111 |

Abbreviations for Address Modes

INH Inherent IMM Immediate DIR Direct EXT Extended REL Relative BSC Bit Set/Clear BTB Bit Test and Branch IX

IX1 Indexed, 1 Byte (8-Bit) Offset IX2

LEGEND Opcode in Hexadecimal 1111 # of Cycles HMOS Versions تع ٥ Opcode in Binary SUB # Bytes 0000 # of Cycles CMOS Versions Address Mode

Indexed (No Offset) Indexed, 2 Byte (16-Bit) Offset

^{*} CMOS Versions Only

MOTOROLA SEMICONDUCTORS

3501 ED BLUESTEIN BLVD., AUSTIN, TEXAS 78721

Advance Information

8-BIT EPROM MICROCOMPUTER UNIT WITH A/D

The MC68705R3 Microcomputer Unit (MCU) is an EPROM member of the M6805 Family of low-cost single-chip microcomputers. The user programmable EPROM allows program changes and lower volume applications in comparison to the factory mask programmable versions. The EPROM versions also reduce the development costs and turnaround time for prototype evaluation of the mask ROM versions. This 8-bit microcomputer contains a CPU, on-chip CLOCK, EPROM, bootstrap ROM, RAM, I/O, A/D Converter, and a TIMER.

Because of these features, the MC68705R3 offers the user an economical means of designing an M6805 Family MCU into his system, either as a prototype evaluation, as a low-volume production run, or a pilot production run

A comparison table of the key features for several members of the M6805 Family is shown on the last page of this data sheet

HARDWARE FEATURES:

- 8-Bit Architecture
- 112 bytes of RAM
- Memory Mapped I/O
- 3776 Bytes of User EPROM
- Internal 8-Bit Timer with 7-Bit Prescaler
 - Programmable Prescaler
- Programmable Timer Input Modes
- 4 Vectored Interrupts External (2), Timer (1), and Software (1)
- Zero-Cross Detection on INT Input
- 24 TTL/CMOS Compatible Bidirectional I/O Lines (8 Lines are LED Compatible)
- 2-to-8 Digital Input Lines
- A/D Converter
 - 8-Bit Conversion, Monotonic
 - 1-to-4 Multiplexed Analog Inputs
 - ± 1/2 LSB Quantitizing Error
 - ± ½ LSB All Other Errors
 - ±1 LSB Total Error (Max)
- Ratiometric ConversionOn-Chip Clock Generator
- Master Reset
- Complete Development System Support on EXORciser®
- 5 V Single Supply
- Emulates the MC6805R2
- Bootstrap Program in ROM Simplifies EPROM Programming

SOFTWARE

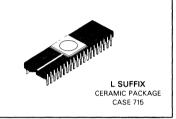
- Similar to M6800 Family
- Byte Efficient Instruction Set
- Easy to Program
- True Bit Manipulation
- Bit Test and Branch Instructions
- Versatile Interrupt Handling
- Versatile Index Registers
- Powerful Indexed Addressing for Tables
- Full Set of Conditional Branches
- Memory Usable as Registers/Flags
- Single Instruction Memory Examine/Change
- 10 Powerful Addressing Modes
- All Addressing Modes Apply to EPROM, RAM, and I/O

MC68705R3

HMOS

(HIGH-DENSITY, N-CHANNEL DEPLETION LOAD, 5 V EPROM PROCESS)

8-BIT EPROM
MICROCOMPUTER WITH A/D



| FIGURE 1 – | · PIN ASSIGNMENTS |
|---|---|
| VSS [1] | 40 PA7 |
| INT [3 VCC [4 EXTAL [6 | 38 PA5 37 PA4 36 PA3 |
| XTAL [6 | 35 1 PA2 34 1 PA1 |
| TIMER/BOOT [8 PC0 [9 PC1 [10 | 33 1 PA0 32 1 PB7 31 1 PB6 |
| PC2 [11 PC3 [12 | 30 1 PB5 29 1 PB4 |
| PC4 [13 PC5 [14 PC6 [15 | 26] PB3 27] PB2 26 1 PB1 |
| PC7 [16 PD7 [17 | 25 1 PB0 24 1 PD0/AN0 |
| PD6/INT2 18 PD5/VRH 19 PD4/VRL 120 | 23 PD1/AN1 22 PD2/AN2 21 PD3/AN3 |
| | FD3/ANS |

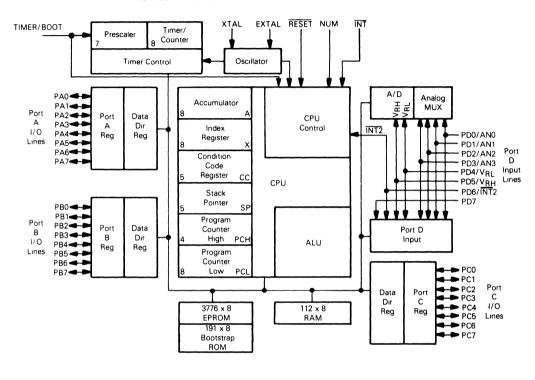


FIGURE 2 - MC68705R3 HMOS MICROCOMPUTER BLOCK DIAGRAM

MAXIMUM RATINGS

| 110 0 1111 10 1111 100 | | | |
|--|------------------|----------------|------|
| Rating | Symbol | Value | Unit |
| Supply Voltage | V _{CC} | -0.3 to +7.0 | ٧ |
| Input Voltage EPROM Programming Voltage (Vpp Pin) TIMER/BOOT Pin | V _{PP} | -0 3 to +22 0 | ٧ |
| Normal Mode | V _{in} | -03 to +70 | V |
| Bootstrap Programming Mode | VBOOT | -30 to +150 | V |
| All Others | V _{in} | -0.3 to +7.0 | ٧ |
| Operating Temperature Range | TA | 0 to +50 | °C |
| Storage Temperature Range | T _{stg} | -55 to +150 | °C |
| Junction Temperature | TJ | + 150 | °C |

This device contains circuitry to protect the inputs against damage due to high static voltages or electric fields, however, it is advised that normal precautions be taken to avoid application of any voltage higher than maximum rated voltages to this high-impedance circuit. For proper operation it is recommended that V_{in} and V_{out} be constrained to the range $V_{SS} \leq |V_{in}$ or $V_{out}| \leq V_{CC}$. Reliability of operation is enhanced if unused inputs are tied to an appropriate logic voltage level (e.g., either V_{SS} or V_{CC})

THERMAL CHARACTERISTICS

| Characteristic | Symbol | Value | Unit |
|--------------------|---------------|-------|------|
| Thermal Resistance | | | |
| Ceramic Package | θ_{JA} | 50 | °C/W |

POWER CONSIDERATIONS

The average chip-junction temperature, T_J, in °C can be obtained from

$$T_{J} = T_{A} + (P_{D} \bullet \theta_{JA})$$
Where

 $T_{\Delta} = Ambient Temperature, °C$

 $\theta_{\text{JA}} = \text{Package Thermal Resistance, Junction-to-Ambient, } ^{\circ}\text{C/W}$

PD≡PINT + PPORT

PINT≡ICC×VCC, Watts - Chip Internal Power

PPORT = Port Power Dissipation, Watts - User Determined

For most applications PPORT ◀PINT and can be neglected PPORT may become significant if the device is configured to drive Darlington bases or sink LED loads

An approximate relationship between PD and TJ (if PPORT is neglected) is

$$P_D = K - (T_J + 273^{\circ}C)$$
 (2)

Solving equations 1 and 2 for K gives

$$K = P_{D} \bullet (T_{\Delta} + 273 \circ C) + \theta_{c} |_{\Delta} \bullet P_{D}^{2}$$
(3)

Where K is a constant pertaining to the particular part. K can be determined from equation 3 by measuring PD (at equilibrium) for a known T_A . Using this value of K the values of PD and T_J can be obtained by solving equations (1) and (2) iteratively for any value of T_A .

PROGRAMMING OPERATION ELECTRICAL CHARACTERISTICS

 $(V_{CC} = 5.25 \text{ Vdc } \pm 0.5, V_{SS} = \text{GND}, T_A = 20^{\circ} \text{ to } 30^{\circ}\text{C} \text{ unless otherwise noted})$

| Characteristic | Symbol | Min | Тур | Max | Unit |
|--|--------|------|--------|---------|------|
| Programming Voltage | Vpp | 20 0 | 21 0 | 22 0 | V |
| Vpp Supply Current | Ірр | _ | _ _ | 8 30 | mA |
| Oscillator Frequency | foscp | 09 | 10 | 11 | MHz |
| Bootstrap Programming Mode Voltage (TIMER/BOOT Pin) @ I _{IHTP} = 100 μA Max | VIHTP | 90 | 12 0 | 15 0 | V |

A/D CONVERTER CHARACTERISTICS (V_{CC} = +5 25 V +0 5 Vdc, V_{SS} = GND, T_A = 0° to 70° Unless Otherwise Noted)

| Characteristic | Min | Тур | Max | Unit | Comments |
|--------------------------------|-----------------|-----|-----------------|------------------|--|
| Resolution | 8 | 8 | 8 | Bits | |
| Non-Linearity | _ | _ | ± 1/2 | LSB | For V _{RH} = 4 0 to 5 0 V and V _{RL} = 0 V |
| Quantitizing Error | _ | - | ± 1/2 | LSB | For V _{RH} =40 to 50 V and V _{RL} =0 V |
| Conversion Range | V _{RL} | | V _{RH} | V | |
| V _{RH} | T = | _ | 50 | V | A/D accuracy may decrease proportionately as |
| V _{RL} | Vss | _ | 02 | V | VRH is reduced below 4.0 V. The sum of VRH and |
| | } | | | | V _{RL} must not exceed V _{CC} |
| Conversion Time | 30 | 30 | 30 | tcyc | Includes sampling time |
| Monotonicity | | Inh | erent (with | nin total error) | |
| Zero Input Reading | 00 | 00 | 01 | hexadecimal | V _{in} = 0 |
| Ratiometric Reading | FF | FF | FF | hexadecimal | V _{In} = V _{RH} |
| Sample Time | 5 | 5 | 5 | tcyc | |
| Sample/Hold Capacitance, Input | T - | _ | 25 | pF | |
| Analog Input Voltage | VRL | - | VRH | ٧ | Negative transients on V _{RL} are not allowed |
| | 1 | 1 | [| | at any time during conversion |

SWITCHING CHARACTERISTICS (V_{CC} = +5 25 Vdc \pm 0 5 Vdc, V_{SS} = GND, T_A = 0° to 50° unless otherwise noted)

| Characteristic | Symbol | Min | Тур | Max | Unit |
|--|----------|------------------------|--------------|-----|------|
| Oscillator Frequency Normal | fosc | 0.4 | _ | 4 2 | MHz |
| Instruction Cycle Time (4/f _{osc}) | tcyc | 0 950 | | 10 | μS |
| INT, INT2 or Timer Pulse Width | tWL, tWH | t _{cyc} + 250 | - | - | ns |
| RESET Pulse Width | tRWL | t _{cyc} + 250 | _ | - | ns |
| RESET Delay Time (External Cap = 1 0 μF) | †RHL | 100 | - | _ | ms |
| INT Zero Crossing Detection Input Frequency (for ±5° Accuracy) | fINT | 0 03 | - | 10 | kHz |
| External Clock Duty Cycle (EXTAL) (See Figure 12) | _ | 40 | 50 | 60 | % |

DC ELECTRICAL CHARACTERISTICS (V_{CC} = $^+$ 5 25 Vdc \pm 0 5 Vdc, V_{SS} = GND, T_A = 0 $^\circ$ to 50 $^\circ$ C unless otherwise noted)

| Characteristic | Symbol | Min | Тур | Max | Unit |
|---|-------------------|---------------------------------|-------------------------|------------------------------|-------------|
| Input High Voltage RESET (4 75≤V _{CC} ≤5 75) (V _{CC} <4 75) | | 4 0 V _{CC} -0 5 | _ | Vcc Vcc | ٧ |
| NT (4 75≤ V _{CC} ≤ 5 75) (V _{CC} < 4 75) All Other | V _{IH} | 40 V _{CC} -05 20 | ** | Vcc Vcc Vcc | V V |
| Input High Voltage (TIMER/BOOT Pin) Timer Mode Bootstrap Programming Mode | VIH | 2 0 9 0 | _ 12 0 | V _{CC} | V V |
| Input Low Voltage RESET INT All Other | V _{IL} | -03 -03 -03 | - ** - | 0 8 1 5 0 8 | V V V |
| Internal Power Dissipation (No Port Loading, V _{CC} =5 25 V, T _A =0°C) | PINT | _ | 600 | TBD • | mW |
| Input Capacitance EXTAL All Other | C _{in} | - | 25 10 | _ _ | pF pF |
| RESET Hysteresis Voltage (See Figure 11) Out of Reset Voltage Into Reset Voltage | VIRES+ VIRES- | 2 1 0 8 | _ _ | 4 0 2 0 | V V |
| Programming Voltage (Vpp Pin) Programming EPROM Operating Mode | V _{PP} ₩ | 20 0 4 0 | 21 0 V _{CC} | 22 0 5 75 | V V |
| Input Current TIMER (V _{In} = 0 4 V) INT (V _{In} = 0 4 V) EXTAL (V _{In} = 2 4 V to V _{CC}) (V _{In} = 0 4 V) RESET (V _{In} = 0 8 V) (External Capacitor Changing Current) | l _{in} | - - - -40 | 20 - - - | 20 50 10 1600 50 | μΑ |

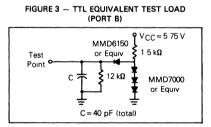
^{*}Vpp is Pin 7 on the MC68705R3 and is connected to V_{CC} in the Normal Operating Mode. In the MC6805R2, Pin 7 is NUM and is connected to V_{SS} in the Normal Operating Mode. The user must allow for this difference when emulating the MC6805R2 ROM-based MCU.

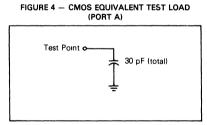
^{**}Due to internal biasing, this input (when not used) floats to approximately 2 0 V

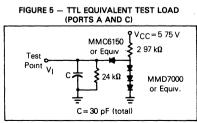
DC PORT ELECTRICAL CHARACTERISTICS (V_{CC}= +5 25 Vdc ± 0.5 Vdc, V_{SS}= GND, T_A=0° to 50°C unless otherwise noted)

| Characteristic | Symbol | Min | Тур | Max | Unit |
|--|------------------|-----|-----|-------|------|
| Port | Α | | | | |
| Output Low Voltage, ILoad=16 mA | V _{OL} | _ | - | 0 4 | V |
| Output High Voltage, I _{Load} = -100 μA | Voн | 2 4 | - | _ | V |
| Output High Voltage, $I_{Load} = -10 \mu A$ | Voh | 35 | | | V |
| Input High Voltage, I _{Load} = -300 μA (Max) | VIH | 20 | _ | Vcc | ٧ |
| Input Low Voltage, ILoad = -500 µA (Max) | V _{IL} | -03 | _ | 0.8 | V |
| Hi-Z State Input Current (V _{IN} = 2 0 V to V _{CC}) | lін | _ | - | - 300 | μΑ |
| Hi-Z State Input Current (V _{IN} = -03 V to +08 V) | IIL | _ | - | -500 | μΑ |
| Port | В | | | | |
| Output Low Voltage, ILoad=3 2 mA | VOL | _ | | 0 4 | V |
| Output Low Voltage, ILoad = 10 mA (Sink) | V _{OL} | | | 10 | V |
| Output High Voltage, I _{Load} = -200 μA | Voн | 2 4 | | _ | ٧ |
| Darlington Current Drive (Source), V _O = 1 5 V | loн | -10 | _ | -10 | mA |
| Input High Voltage | ViH | 20 | | Vcc | ٧ |
| Input Low Voltage | VIL | -03 | | 0.8 | ٧ |
| Hi-Z State Input Current | ^I TSI | | 2 | 20 | μΑ |
| Port | С | | | | |
| Output Low Voltage, I _{Load} = 1 6 mA | VOL | | _ | 04 | V |
| Output High Voltage, I _{Load} = -100 μA | VoH | 2 4 | | | ٧ |
| Input High Voltage | V _{IH} | 20 | _ | Vcc | ✓ |
| Input Low Voltage | V _{IL} | -03 | _ | 0.8 | ٧ |
| Hi-Z State Input Current | ITSI | _ | 2 | 20 | μΑ |
| Port D (Inp | ut Only) | | | | |
| Input High Voltage | V _{IH} | 20 | _ | Vcc | ٧ |
| Input Low Voltage | VIL | -03 | | 0.8 | V |
| Input Current* | l _{in} | _ | _ | 20 | μΑ |

^{*}The A/D conversion resistor (nominal 11.6 k Ω) is connected internally between PD5/VRH and PD4/VRL







SIGNAL DESCRIPTION

The input and output signals for the MCU, shown in Figure 1, are described in the following paragraphs

 \mbox{VCC} and \mbox{VSS} — Power is supplied to the MCU using two pins \mbox{VCC} is power and \mbox{VSS} is the ground connection

INT — This pin allows an external event to asynchronously interrupt the processor. It can also be used as a polled input using the BIL and BIH instructions. Refer to INTERRUPTS for additional information.

XTAL and EXTAL — These pins provide connections to the on-chip clock oscillator circuit. A crystal, a resistor, or an external signal, depending on the CLK bit (see MASK OPTIONS), is connected to these pins to provide a system clock source with various stability/cost tradeoffs. Lead lengths and stray capacitance on these two pins should be minimized. Refer to INTERNAL CLOCK GENERATOR OPTIONS for recommendations about these inputs.

TIMER/BOOT — This pin is used as an external input to control the internal timer/circuitry. This pin also detects a higher voltage level used to initiate the bootstrap program (see PROGRAMMING FIRMWARE). Refer to TIMER for additional information about the timer circuitry.

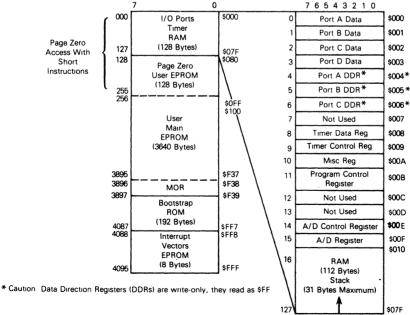
RESET — This pin has a Schmitt Trigger input and an onchip pullup. The MCU can be reset by pulling RESET low Refer to RESETS for additional information. **Vpp** — This pin is used when programming the EPROM By applying the programming voltage to this pin, one of the requirements is met for programming the EPROM In normal operation, this pin is connected to V_{CC} Refer to PROGRAMMING FIRMWARE and ELECTRICAL CHARACTERISTICS

INPUT/OUTPUT LINES (PA0-PA7, PB0-PB7, PC0-PC7, PD0-PD7) — These 32 lines are arranged into four 8-bit ports (A, B, C, and D) Ports A, B, and C are programmable seither inputs or outputs, under software control of the Data Direction Register (DDRs) Port D has up to four analog inputs, plus two voltage reference inputs when the A/D is used (VRH, VRL), an $\overline{\text{INT2}}$ input, and from one to eight digital inputs All port D lines can be directly read and used as binary inputs. If any analog input is used, then the voltage reference pins (VRH, VRL) must be used in the analog mode. Refer to INPUT/OUTPUT, A/D CONVERTER, and INTERRUPTS for additional information.

MEMORY

As shown in Figure 6, the MCU is capable of addressing 4096 bytes of memory and I/O registers with its program counter. The MCU has implemented 4092 bytes of these locations. This consists of: 3776 bytes of user EPROM, 191 bytes of bootstrap ROM, 112 bytes of user RAM, and EPROM Mask Option Register (MOR), and Program Control Register (PCR), seven bytes of I/O, two Timer Registers, a Miscellaneous Register, and two A/D Registers. The user EPROM is located in two areas. The main EPROM area is memory locations \$080 to \$F37. The second area is reserved.

FIGURE 6 — MCU MEMORY MAP



for eight interrupt/reset vector bytes at memory locations \$FF8 to \$FFF. The MCU uses 13 of the lowest 16 memory locations for program control and I/O features such as ports, the port DDRs, the timer, and A/D registers The Mask Option Register at memory location \$F38 completes the total. The 112 bytes of user RAM include up to 31 bytes for the stack

The shared stack area is used during the processing of interrupt and subroutine calls. The contents of the MCU registers are pushed onto the stack in the order shown in Figure 7. Since the Stack Pointer decrements during pushes, the low order byte (PCL) of the Program Counter is stacked first; then the higher order four bits (PCH) are stacked. This ensures that the program counter is loaded correctly as the stack pointer increments when it pulls data from the stack. A subroutine call causes only the Program Counter (PCL, PCH) contents to be pushed onto the stack.

CENTRAL PROCESSING UNIT

The CPU of the M6805 Family is implemented independently from the I/O or memory configuration. Consequently, it can be treated as an independent central processor communicating with I/O and memory via internal address, data, and control buses.

REGISTERS

The CPU has five registers available to the programmer. They are shown in Figure 8 and are explained in the following paragraphs.

ACCUMULATOR (A) — The accumulator is a general purpose 8-bit register used to hold operands and results of the arithmetic calculations or data manipulations.

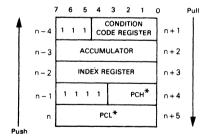
INDEX REGISTER (X) — The index register is an 8-bit register used for the indexed addressing mode. It contains an 8-bit value that may be added to an instruction value to create an effective address. The index register can also be used for data manipulations using read/modify/write instructions. The index register may also be used as a temporary storage area.

PROGRAM COUNTER (PC) — The program counter is a 12-bit register that contains the address of the next instruction to be executed.

STACK POINTER (SP) — The stack pointer is a 12-bit register that contains the address of the next free location on the stack. During an MCU reset or the Reset Stack Point (RSP) instruction, the stack pointer is set to location \$07F. The stack pointer is then decremented as data is pushed onto the stack and incremented as data is then pulled from the stack. The seven most significant bits of the stack point are permanently set to 0000011 Subroutines and interrupts may be nested down to location \$061 (31 bytes maximum), which allows the programmer to use up to 15 levels of subroutine calls (less if interrupts are allowed)

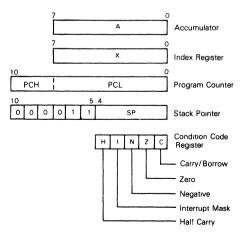
CONDITION CODE REGISTER (CC) — The condition code register is a 5-bit register in which four bits are used to indicate the results of the instruction just executed. These bits can be individually tested by a program and specific action taken as a result of their state. Each of the five bits is explained below.

FIGURE 7 - INTERRUPT STACKING ORDER



^{*}For subroutine calls, only PCL and PCH are stacked

FIGURE 8 - PROGRAMMING MODEL



Half Carry (H) — Set during ADD and ADC operations to indicate that a carry occurred between bits 3 and 4

Interrupt (I) — When this bit is set the timer and external interrupt ($\overline{\text{INT}}$) are masked (disabled). If an interrupt occurs while this bit is set, the interrupt is latched and is processed as soon as the interrupt bit is cleared.

Negative (N) — When set, this bit indicates that the result of the last arithmetic, logical, or data manipulation was negative (bit 7 in the result is a logical one)

Zero (Z) — When set, this bit indicates that the result of the last arithmetic, logical, or data manipulation was zero

Carry/Borrow (C) — When set, this bit indicates that a carry or borrow out of the arithmetic logic unit (ALU) occurred during the last arithmetic operation. This bit is also affected during bit test and branch instructions plus shifts and rotates.

TIMER

The MCU timer consists of an 8-bit software programmable counter which is driven by a 7-bit prescaler with selectable taps. Various timer clock sources may be selected ahead of the prescaler and counter. The timer selections are made via the Timer Control Register (TCR) and/or the Mask Option Register (MOR). The TCR also contains the interrupt control bits. The sections elsewhere entitled TIMER CONTROL REGISTER and MASK OPTIONS include additional details on controlling this timer.

The MCU timer circuitry is shown in Figure 9 The 8-bit counter may be loaded under program control and is decremented toward zero by the fCIN counter input (output of the prescaler option selection) Once the 8-bit counter has decremented to zero, it sets the TIR (Timer Interrupt Request) bit 7 (b7 of TCR) The TIM (Timer Interrupt Mask) bit (b6) can be software set to inhibit the interrupt request, or software cleared to pass the interrupt request to the processor When the I-bit in the Condition Code Register is cleared, the processor receives the Timer Interrupt. The CPU responds to this interrupt by saving the present CPU state on the stack, fetching the timer interrupt vector from locations \$FF8 and \$FF9 and executing the interrupt routine. The processor is sensitive to the level of the timer interrupt request line, therefore if the interrupt is masked, the TIR bit may be cleared by software (e.g., BCLR) without generating an interrupt. The TIR bit MUST be cleared, by the timer interrupt service routine, to clear the timer interrupt register

The timer interrupt and $\overline{\text{INT2}}$ share the same interrupt vector. The interrupt routine thus must check the two request bits to determine the source of the interrupt

The counter continues to count (decrement) after falling through to \$FF from zero. Thus, the counter can be read at any time by the processor without disturbing the count. This allows a program to determine the length of time since the occurrence of a timer interrupt and does not disturb the counting process.

The clock input to the timer can be from an external source (decrementing the counter occurs on a positive transition of the external source) applied to the TIMER input pin,

or it can be the internal $\phi2$ signal. When the $\phi2$ signal is used as the source, it can be gated by an input applied to the TIMER pin allowing the user to easily perform pulse-width measurements. (Note When the MOR TOPT bit is set and the CLS bit is clear, an ungated $\phi2$ clock input is obtained by trying the TIMER pin to VCC.) The source of the clock input is selected via the TCR or the MOR as described later

A prescaler option can be applied to the clock input that extends the timing interval up to a maximum of 128 counts before decrementing the counter. This prescaling TCR or MOR option selects one of eight taps on the 7-bit binary divider, the eighth tap bypasses prescaling. To avoid truncation errors, the prescaler is cleared when bit b3 of the TCR is written to a logic "1". TCR bit b3 always reads as a logic "0" to ensure proper operation with read/modify/write instructions (bit set and clear for example).

At Reset, the prescaler and counter are initialized to an all "1s" condition, the Timer Interrupt Request bit (TCR, b7) is cleared and the Timer Interrupt Request mask (TCR, b6) is set TCR bits 60 through b5 are initialized by the corresponding Mask Option Register (MOR) bits at Reset They are then software selectable after Reset

Note that the timer block diagram in Figure 9 reflects two separate timer control configurations a) software controlled mode via the Timer Control Register (TCR), and b) MOR controlled mode to emulate a mask ROM version with the Mask Option Register. In the software controlled mode, all TCR bits are read/write, except bit b3 which is write-only (always reads as a logic "0"). In the MOR controlled mode, TCR bits b7 and b6 are read/write, bit b3 is write-only, and the other five have no effect on a write and read as logic "1s". The two configurations provide the user with the capability to freely select timer options as well as accurately emulate the MC6805R2 mask ROM version. In the following paragraphs refer to Figure 9 as well as the TIMER CONTROL REGISTER and MASK OPTIONS sections.

The TOPT (Timer Option) bit (b6) in the Mask Option Register is EPROM programmed to a logical "0" to select the software controlled mode, which is described first TCR bits b5, b4, b3, b2, b1, and b0 give the program direct control of the prescaler and input selection options

The Timer Prescaler input (fpIN) can be configured for three different operating modes, plus a disable mode, depending upon the value written to TCR, control bits b4 and b5 (TIE and TIN) Refer to TIMER CONTROL REGISTER section

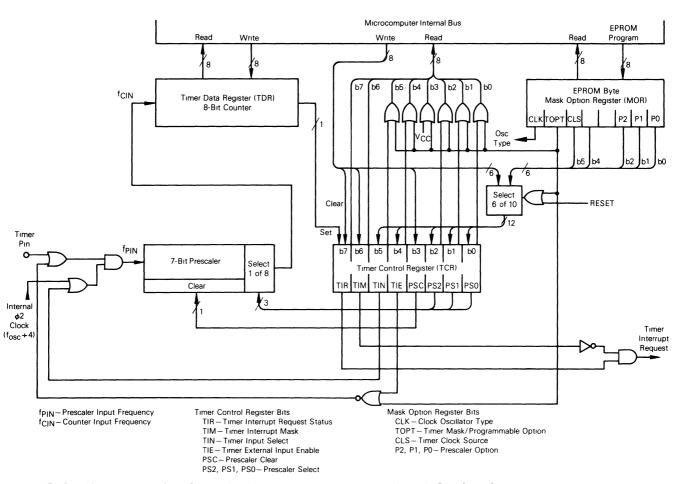
When the TIE and TIN bits are programmed to "0", the timer input is from the internal clock (ϕ 2) and TIMER input pin is disabled. The internal clock mode can be used for periodic interrupt generation as well as a reference for frequency and event measurement

When TIE=1 and TIN=0, the internal clock and the TIMER input pin signals are ANDed to form the timer input This mode can be used to measure external pulse widths The external pulse simply gates to the internal clock for the duration of the pulse. The accuracy of the count in this mode is \pm one count

When TIE=0 and TIN=1, no fp_{\mbox{\scriptsize IN}} input is applied to the prescaler and the timer is disabled

When TIE and TIN are both programmed to a "1", the timer is from the external clock. The external clock can be

FIGURE 9 - MC68705R3 TIMER FUNCTIONAL BLOCK DIAGRAM



NOTE The TOPT bit in the Mask Option Register selects whether the timer is software programmable via the Timer Control Register or emulates the mask programmable ports via the MOR PROM byte

used to count external events as well as provide an external frequency for generating periodic interrupts

Bits b0, b1, and b2 in the TCR are program controlled to choose the appropriate prescaler output. The prescaling divides the fpIN frequency by 1, 2, 4, etc. in binary multiples to 128 producing fcIN frequency to the counter. The processor cannot write into or read from the prescaler, however, the prescaler is set to all "15" by a write operation to TCR, b3 (when bit 3 of the written data equals "1"), which allows for truncation-free counting

The MOR controlled mode of the timer is selected when the TOPT (Timer Option) bit (b6) in the MOR is programmed to a logical "1" to emulate the MC6805R2 mask-programmable prescaler. The timer circuits are the same as described above, however, the Timer Control Register (TCR) is configured differently, as discussed below.

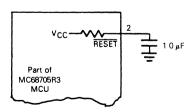
The logical level for the functions of bits b0, b1, b2, and b5 in the TCR are all determined at the time of EPROM programming. They are controlled by corresponding bits within the Mask Option Register (MOR, \$F38) The value programmed into MOR bits b0, b1, b2, and b5 controls the prescaler division and the timer clock selection. Bit b4 (TIE) is set to a logical "1" in the MOR controlled mode (When read by software, these five TCR bits always read as logical "1s") As in the software programmable configuration, the TIM (b6) and TIR (b7) bits of the TCR are controlled by the counter and software as described above and in the TIMER CONTROL REGISTER section. Bit b3 of the TCR, in the MOR controlled mode, always reads as a logical "0" and can be written to a logical "1" to clear the prescaler. The MOR controlled mode is designed to exactly emulate the MC6805R2 which has only TIM, TIR, and PSC in the TCR and has the prescaler options defined as manufacturing mask options

RESETS

The MCU can be reset in two ways by initial power-up, and by the external reset input (RESET). Upon power-up, a delay of tRHL is needed before allowing the RESET input to go high. This time allows the internal clock generator to stabilize. Connecting a capacitor to the RESET input, as shown in Figure 10, typically provides sufficient delay.

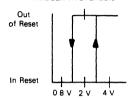
The internal circuit connected to the RESET pin consists of a Schmitt trigger which senses the RESET line logic level

FIGURE 10 - POWER-UP RESET DELAY CIRCUIT



The Schmitt trigger provides an internal reset voltage when it senses logical "0" on the RESET pin During power-up, the Schmitt trigger switches on (removes reset) when the RESET pin voltage rises to VIRES + When the RESET pin voltage falls to a logical "0" for a period longer than one toyo, the Schmitt trigger switches off to provide an internal reset voltage. The "switch off" voltage occurs at VIRES - A typical reset Schmitt trigger hysteresis curve is shown in Figure 11. See Figure 15 for the complete reset sequence.

FIGURE 11 — TYPICAL RESET SCHMITT TRIGGER HYSTERESIS



INTERNAL CLOCK GENERATOR OPTIONS

The internal clock generator circuit is designed to require a minimum of external components. A crystal, a resistor, a jumper wire, or an external signal may be used to generate a system clock with various stability/cost tradeoffs. The Mask Option Register (EPROM) is programmed to select crystal or resistor operation. The oscillator frequency is internally divided by four to produce the internal system clocks.

The different connection methods are shown in Figure 12 Crystal specifications are given in Figure 13 A resistor selection graph is given in Figure 14

The crystal oscillator start-up time is a function of many variables crystal parameters (especially $R_{\rm S}$), oscillator load capacitances, IC parameters, ambient temperature, and supply voltage. To ensure rapid oscillator start-up neither the crystal characteristics nor the load capacitances should exceed recommendations.

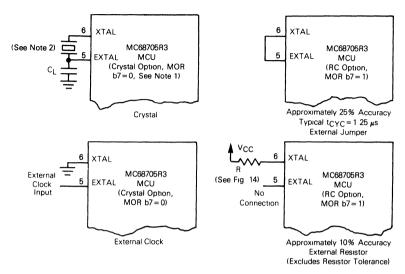
BOOTSTRAP ROM

The bootstrap ROM contains a factory program which allows the MCU to fetch data from an external device and transfer it into the MC68705R3 EPROM. The bootstrap program provides timing of programming pulses, timing of Vpp input, and verification after programming. See PROGRAMMING FIRMWARE section.

MASK OPTION REGISTER (MOR)

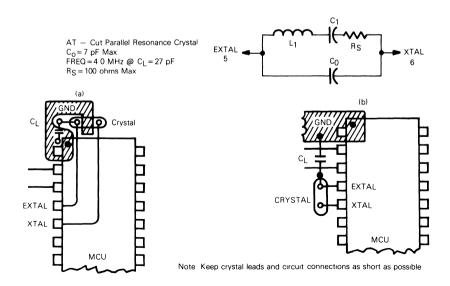
The Mask Option Register is an 8-bit user programmed (EPROM) register in which six of the bits are used. Bits in this register are used to select the type of system clock, the timer option, the timer/prescaler clock source, and the prescaler option. It is fully described in the MASK OPTIONS section.

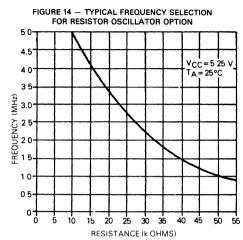
FIGURE 12 - CLOCK GENERATOR OPTIONS



- NOTE 1 When the TIMER/BOOT input pin is in the V_{IHTP} range (in the bootstrap EPROM programming mode), the crystal option is forced When the TIMER/BOOT input is at or below V_{CC}, the clock generator option is determined by bit 7 of the Mask Option Register (CLK)
 - 2 The recommended C_L value with a 4 0 MHz crystal is 27 pF maximum, including system distributed capacitance. There is an internal capacitance of approximately 25 pF on the XTAL pin. For crystal frequencies other than 4 MHz, the total capacitance on each pin should be scaled as the inverse of the frequency ratio. For example, with a 2 MHz crystal, use approximately 50 pF on EXTAL and approximately 25 pF on XTAL. The exact value depends on the Motional-Arm parameters of the crystal used.

FIGURE 13 — CRYSTAL MOTIONAL-ARM PARAMETERS AND SUGGESTED PC BOARD LAYOUT

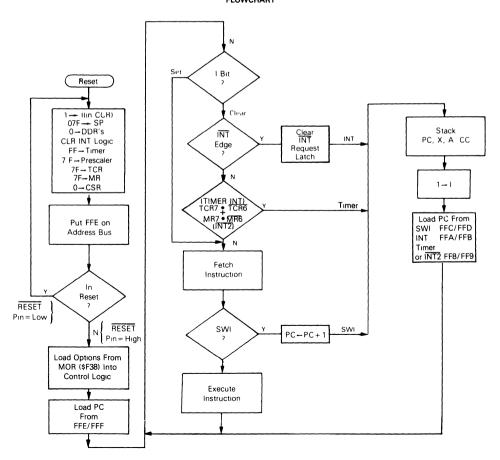




INTERRUPTS

The MCU can be interrupted four different ways through the external interrupt (INT) input pin, the internal timer interrupt request, the external Port C bit 6 (INT2) input pin, or the software interrupt instruction (SWI) When any interrupt occurs the current instruction (including SWI) is completed. processing is suspended, the present CPU state is pushed onto the stack, the interrupt bit (I) in the Condition Code Register is set, the address of the interrupt routine is obtained from the appropriate interrupt vector address, and the interrupt routine is executed Stacking the CPU register, setting the I-bit, and vector fetching require a total of 11 t_{CVC} periods for completion. A flowchart of the interrupt sequence is shown in Figure 15. The interrupt service routine must end with a return from interrupt (RTI) instruction which allows the MCU to resume processing of the program prior to the interrupt (by unstacking the previous CPU state) Table 1 provides a listing of the interrupts, their priority, and the address of the vector which contains the starting address

FIGURE 15 — RESET AND INTERRUPT PROCESSING FLOWCHART



of the appropriate interrupt service routine. The interrupt priority applies to those pending when the CPU is ready to accept a new interrupt. (RESET is listed in Table 1 because it is treated as an interrupt. However, it is not normally used as an interrupt.) When the interrupt mask bit in the Condition Code Register is set the interrupt is latched for later interrupt execution.

Note

The timer and NT2 share the same vector address. The interrupt routine must determine the source by examining the interrupt request bits (TCR b7 and MR b7). Both TCR b7 and MR b7 can only be written to "0" by software.

The external interrupt, $\overline{\text{INT}}$ and $\overline{\text{INT2}}$, are synchronized and then latched on the falling edge of the input signal. The $\overline{\text{INT2}}$ interrupt has an interrupt request bit (bit 7) and a mask bit (bit 6) located in the Miscellaneous Register (MR), refer to Figure 18. The $\overline{\text{INT2}}$ interrupt is inhibited when the mask bit is set. The $\overline{\text{INT2}}$ is always read as a digital input on Port D. The $\overline{\text{INT2}}$ and timer interrupt request bits, if set, cause the MCU to process an interrupt when the condition code I-bit is clear.

A sinusoidal input signl (fint maximum) can be used to generate an external interrupt, as shown in Figure 16a, for use as a Zero-Crossing Detector. This allows applications such as servicing time-of-day routines and engaging/disengaging AC power control devices. Off-chip full wave rectification provides an interrupt at every zero crossing of the AC signal and thereby provide a 2f clock. For digital application the INT pin can be driven by a digital signal at a maximum period of twill as shown in Figure 16b

A software interrupt (SWI) is an executable instruction which is executed regardless of the state of the I-bit in the Condition Code Register. SWI's are usually used as breakpoints for debugging or as system calls

TABLE 1 - INTERRUPT PRIORITIES

| Interrupt | Priority | Vector Address |
|------------|----------|-----------------|
| RESET | 1 | \$FFE and \$FFF |
| SWI | 2* | \$FFC and \$FFD |
| ĪÑŦ | 3 | \$FFA and \$FFB |
| TIMER/INT2 | 4 | \$FF8 and \$FF9 |

★ Priority 2 applies only when the I-bit in the Condition Code Register is set (as when a service routine is occurring) When I = 0 and all interrupts are being accepted, SWI has a priority of 4 (like any other instruction) The priority of INT thus becomes 2 and the timer becomes 3

FIGURE 16 - TYPICAL INTERRUPT CIRCUITS

a - Zero Crossing Interrupt

b - Dıgıtal Signal Interrupt



INPUT/OUTPUT

There are 32 input/output pins. The INT pin may be polled with branch instructions to provide an additional input pin. All pins on ports A, B, and C are programmable as either inputs or outputs under software control of the corresponding Data Direction Register (DDR). The port I/O programming is accomplished by writing the corresponding bit in the port DDR to a logic "1" for output or a logic "0" for input. On Reset all the DDRs are initialized to a logic "0" state, placing the ports in the input mode. The port output registers are not initialized on Reset and should be initialized by software before changing the DDRs from input to output. When programmed as outputs, all output ports read latched output data, regardless of the logic levels at the output pin due to output loading, refer to Figure 17

All input/output lines are TTL compatible as both inputs and outputs Port A lines are CMOS compatible as outputs while port B, C, and D lines are CMOS compatible as inputs Port D lines are input only, thus, there is no corresponding DDR When programmed as outputs, port B is capable of sinking 10 milliamperes and sourcing 1 0 milliampere on each pin.

Port D provides the multiplexed analog inputs, reference voltage, and $\overline{\text{INT2}}$ All of these lines are shared with the port D digital inputs Port D may always be used as digital inputs and may also be used as analog inputs. The VRL and VRH lines (PD4 and PD5) are internally connected to the A/D

resistor. Analog inputs may be prescaled to attain the V_{RL} to V_{RH} recommended input voltage.

The memory map in Figure 6 gives the addresses of data registers and DDRs. The register configuration is provided in Figure 18. Figure 19 provides some example of port connections.

Caution

The corresponding DDRs for ports A, B, and C are write-only registers (registers at \$004, \$005, and \$006) A read operation on these registers is undefined Since BSET and BCLR are read/modify/write in function, they cannot be used to set or clear a single DDR bit (all "unaffected" bits would be set). It is recommended that all DDR bits in a port must be written using a single-store instruction.

The latched output data bit (see Figure 17) may always be written. Therefore, any write to a port writes all of its data bits even though the port DDR is set to input. This may be used to initialize the data register and avoid undefined outputs, however, care must be exercised when using read/modify/write instruction since the data read corresponds to the pin level if the DDR is an input (0) and corresponds to the latched output data when the DDR is an output (1)

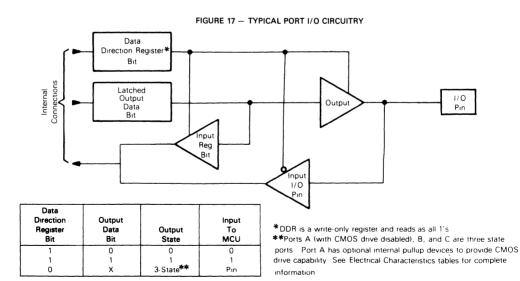


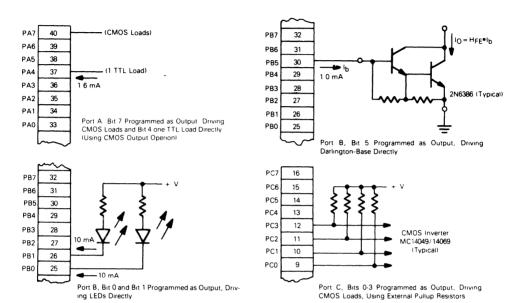
FIGURE 18 - MCU REGISTER CONFIGURATION

| PORT DATA DIRECTION REGISTER (DD 7 (1) Write Only, reads as all 1s (2) 1= Output, 0= Input Cleared to 0 (3) Port A Addr = \$004 Port B Addr = \$005 Port C Addr = \$006 | 0 | | | | 7 | PORT DATA REGISTER 0 Port A Addr = \$000 Port B Addr = \$001 Port C Addr = \$002 Port D Addr = \$003 |
|--|-----------|----------|--------------|--------------|----------------|--|
| 7 M | | ATA REC | GISTER | (TDF | O LSB | \$008 |
| MISCELLANEOUS REGISTER (MR) 7 6 1 1 1 1 1 1 1 Bit 7—INT2 Interrupt Request Bit Set whe edge detected on INT2 pin, must be compared to the edge detected to the edge detected on INT2 pin, must be compared to the edge detected to the edge dete | | | | Bıt | | A/D CONTROL REGISTER (ACR) 2 1 0 1 1 1 1 1 \$0000 version Complete Status Flag Set when conon is complete, Cleared only on a write to |
| $ \begin{array}{llllllllllllllllllllllllllllllllllll$ | | | | | ACR 2, 1, 0 | , readable, not writable — A/D Input Mux Selection (see Table 2) 3 — read as 1s — unused bits |
| 7 | A/D RES | SULT REC | GISTER | R (ARI | O LSB | \$00F |
| | TIMER CON | NTROL R | EGISTI | ER (TO | CR) | |
| See det section | 6 5 | | 3 2 ER CO | \mathbb{L} | I |] \$009 STER |
| | MASK O | 4 | 3 2 | 1 | 0 |] \$F38 on |
| PRO 7 | OGRAMMIN | IG CONT | ROL R 3 | EGIST 2 | ER (PCF | 3) |
| , | | | | | Ť | \$00B |

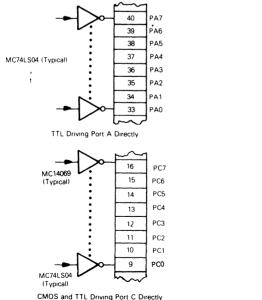
See detail description in ON-CHIP PROGRAMMING HARDWARE section

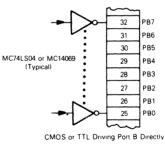
FIGURE 19 - TYPICAL PORT CONNECTIONS

a. Output Modes



b. Input Modes





PDO: ANO ANO-PD1/AN1 ΔN1-4 23 AN2-22 PD2/AN2 21 PD3-AN3 ΔN3~ 0 V 20 VRL 19 + 5 V VRH 18 PD6/INT2 PD7 MC14069

Port D used as 4-Channel A/D Input with Bit 7 used as CMOS Digital Input

ANALOG-TO-DIGITAL CONVERTER (A/D) — The MCU has an 8-bit A/D converter implemented on the chip using a successive approximation technique, as shown in Figure 20 Up to four external analog inputs, via port D, are connected to the A/D through a multiplexer Four internal analog signals may be selected for calibration purposes (V_{RH} , V_{RH} /2, V_{RH} /4, and V_{RI})

The multiplexer selection is controlled by the A/D Control Register (ACR) bits 0, 1, and 2, see Table 2 This register is cleared during any Reset condition. Refer to Figure 18 for Register Configuration.

Whenever the ACR is written, the conversion in progress is aborted, the conversion complete flag (ACR bit 7) is cleared, and the selected input is sampled and held internally

The converter operates continuously using 30 machine cycles to complete a conversion of the sampled analog input When conversion is complete, the digitized sample or digital value is placed in the A/D Result Register (ARR), the conversions of the A/D Result Register (ARR), the conversions of the A/D Result Register (ARR).

sion complete flag is set, the selected input is sampled again, and a new conversion is started

The A/D is ratiometric. Two reference: voltages (VRH and VRL) are supplied to the converter via port D pins. An input voltage equal to VRH converts to \$FF (full scale) and an input voltage equal to VRL converts \$00. An input voltage greater than VRH converts to \$FF and no overflow indication is provided. For ratiometric conversions, the source of each analog input should use VRH as the supply voltage and be referenced to VRL.

Caution

This device contains circuitry to protect the inputs against damage due to high static voltages or electric fields, however, the design of the input circuitry for the analog reference voltage pins (19 and 20) does not offer the SAME level of protection. Precautions should be taken to avoid applications of any voltage higher than maximum-rated voltage or handled in any environment producing high-static voltages.

FIGURE 20 - A/D BLOCK DIAGRAM

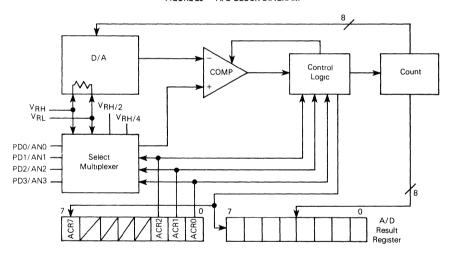


TABLE 2 - A/D INPUT MUX SELECTION

| | A/D | Control Re | l C-l | |
|---|------|------------|-------|---------------------|
| | ACR2 | ACR1 | ACRC | Input Selected |
| ſ | 0 | 0 | 0 | AN0 |
| 1 | 0 | 0 | 1 | AN1 |
| 1 | 0 | 1 | 0 | AN2 |
| 1 | 0 | 1 | 1 | AN3 |
| | 1 | 0 | 0 | ∨ _{RH} * |
| | 1 | 0 | 1 | V _{RL} * |
| | 1 | 1 | 0 | V _{RH/4} * |
| | 1 | 1 | 1 | V _{RH/2} * |

^{*}Internal (Calibration) levels

TIMER CONTROL REGISTER (TCR)

The configuration of the TCR is determined by the logic level of bit 6 (Timer Option, TOPT) in the Mask Option Register (MOR). Two configurations of the TCR are shown below, one for TOPT=1 and the other for TOPT=0 TOPT=1 configures the TCR to emulate the MC6805R2. When TOPT=0, it provides software control of the TCR When TOPT=1, the prescaler "mask" options are user programmable via the MOR. A description of each TCR bit is provided below (also see Figure 9 and TIMER section)

| b7 | b 6 | b5 | b4 | b3 | b2 | b1 | b0 | |
|-----|------------|----|----|------|----|----|----|--------------------------------|
| TIR | TIM | 1 | 1 | PSC* | 1 | 1 | 1 | Timer Contro Register \$009 |

TCR with MOR TOPT = 1 (MC6805R2 Emulation)

| | | | | | b2 | | | |
|-----|-----|-----|-----|------|-----|-----|-----|--------------|
| TIR | TIM | TIN | TIE | PSC* | PS2 | PS1 | PS0 | Timer Contro |

TCR with MOR TOPT = 0 (Software Programmable Timer)

* = write only, reads as a zero

b7, TIR Timer Interrupt Request—Used to initiate the timer interrupt or signal a timer Data Register underflow when it is a logical "1"

1 = Set when the Timer Data Register changes to all zeros

0= Cleared by external reset or under program control

b6, TIM Timer Interrupt Mask—Used to inhibit the timer interrupt, to the processor, when it is a logical "1"

1 = Set by an external reset or under program control.

0 = Cleared under program control

b5, TIN External or Internal—Selects the input clock source to be either the external TIMER pin (8) or the internal \$\phi 2\$

1 = Selects the external clock source 0 = Selects the internal ϕ 2 (fosc + 4)

b4, TIE External Enable—Used to enable the external TIMER pin (8) or to enable the internal clock (if TIN=0) regardless of the external timer pin state (disables gated clock feature). When TOPT=1, TIE is always a logical "1"

1 = Enables external timer pin

0 = Disables external timer pin.

TIN-TIE Modes

| TIN | TIE | CLOCK |
|-----|-----|-----------------------------|
| 0 | 0 | Internal Clock (\phi2) |
| 0 | 1 | Gated (AND) of External and |
| 1 | | Internal Clocks |
| 1 | 0 | No Clock |
| 1 | 1 | External Clock |

b3, PSC Prescaler Clear – This is a write-only bit. It reads as a logical zero so the BSET and BCLR on the TCR function correctly. Writing a "1" into PSC generates a pulse which clears the prescaler.

b2, PS2 Prescaler Select – These bits are decoded b1, PS1 to select one of eight taps on the timer prescaler

b0, PS0 The table shows the prescaler division resulting from decoding these bits

| PS2 | PS1 | PS0 | Prescaler Division |
|------|-----|------|----------------------|
| 0 | 0 | 0 | 1 (Bypass Prescaler) |
| 0 | 0 | 1 | 2 |
| 0 | 1 | 0 | 4 |
| 0 | 1 | 1 | 8 |
| 1 | 0 | 0 | 16 |
| 1 | 0 | 1 | 32 |
| 1 | 1 | 0 | 64 |
| 1_1_ | 1 | 1_1_ | 128 |

Note

When changing the PS2-0 bits in software, the PSC bit should be written to a "1" in the same write cycle to clear the prescaler Changing the PS bits without clearing the prescaler may cause an extraneous toggle of the Timer Data Register

MASK OPTIONS

The MC68705R3 Mask Option Register is implemented in EPROM. Like all other EPROM bytes, the MOR contains all zeros prior to programming.

When used to emulate the MC6805R2, five of the eight MOR bits are used in conjunction with the prescaler. Of the remaining, the b7 bit is used to select the type of clock oscillator and bits b3 and b4 are not used. Bits b0, b1, and b2 determine the division the Timer prescaler. Bit b5 determines the Timer clock source. The value of the TOPT bit (b6) is programmed to configure the TCR (a logic "1" for MC6805R2 emulation).

If the MOR Timer Option (TOPT) bit is a 0, bits b5, b4, b2, b1, and b0 set the initial value of their respective TCP bits during reset. After initialization the TCR is software controllable.

A description of the MOR bits is as follows

| | | | | | | | Mask Option |
|-----|------|-----|------|----|----|----|----------------|
| CLK | TOPT | CLS | | P2 | P1 | P0 | Register \$F38 |

b7, CLK Clock Oscillator Type 1 = RC 0 = Crystal

Note

VINTP on the TIMER/BOOT pin (8) forces the crystal mode

b6, TOPT Timer Option

1= MC6805R2 type timer/prescaler All bits, except 3, 6, and 7, of the Timer Control Register (TRC) are invisible to the user Bits 5, 2, 1, and 0 of the Mask Option Register determine the equivalent MC6805R2 mask options

C = All TCR bits are implemented as a Software Programmable Timer. The state of bits 5, 4, 2, 1, and 0 set the initial values of their respective TCR bits (TCR is then software controlled after initialization)

b5, CLS Timer/Prescaler Clock Source 1 = External TIMER pin $0 = Internal \phi 2$ Not used if MOR TOPT = 1 (MC6805R2 emulation) b4 Sets initial value of TCR TIE if MOR TOPT = 0 b3 Not used b2. P2 Prescaler Option - the logical levels of these b1, P1 bits, when decoded, select one of eight taps ь0, Р0 on the timer prescaler. The table below shows the division resulting from decoding combinations of these three bits

| P2 | P1 | P0 | Prescaler Division |
|-----|----|----|----------------------|
| 0 | 0 | 0 | 1 (Bypass Prescaler) |
| 0 | 0 | 1 | 2 |
| 0 | 1 | 0 | 4 |
| 0 | 1 | 1 | 8 |
| 1 | 0 | 0 | 16 |
| 1 | 0 | 1 | 32 |
| 1 | 1 | 0 | 64 |
| 1 1 | 1 | 1 | 128 |

Two examples for programming the MOR are discussed below

Example 1 To emulate an MC6805R2 to verfiy your program with an RC oscillator, and an event count input for the timer with no prescaling, the MOR would be set to "11111000" To write the MOR, it is simply programmed as any other EPROM byte

Example 2 Suppose you wish to use the MC68705R3 programmable prescaler functions, and you wish the initial condition of the prescaler to be divided by 64, with the input disabled and an internal clock source. If the clock oscillator was to be in the crystal mode, the MOR would be set to "00001110"

ON-CHIP PROGRAMMING HARDWARE

The Programming Control Register (PCR) at location \$00B is an 8-bit register which utilizes the three LSBs (the five MSBs are set to logic "1s") This register provides the necessary control bits to allow programming the MC68705R3 EPROM The bootstrap program manipulates the PCR when programming so that users need not be concerned with the PCR in most applications. A description of each bit follows

| b7 | b6 | b5 | b4 | b3 | b2 | b1 | ь0 | Programming Control |
|----|----|----|----|----|------|-----|-----|------------------------|
| 1 | 1 | 1 | 1 | 1 | VPON | PGE | PLE | Register \$00B |

b0, PLE Programming Latch Enable—When cleared this bit allows the address and data to be latched into the EPROM When this bit is set, data can be read from the EPROM

1= (set) read EPROM

0=(clear) latch address and data into EPROM (read disabled)

PLE is set during a Reset, but may be cleared any time However, its effect on the EPROM is inhibited if VPON is a logic "1" b1, PGE Program Enable—When cleared, PGE enables programming of the EPROM. PGE can only be cleared if PLE is cleared PGE must be set when changing the address and data, i.e., setting up the byte to be programmed

1= (set) inhibit EPROM programming

0=(clear) enable EPROM programming (if PLE is low)

PGE is set during a Reset, however, it has not effect on EPROM circuits if VPON is a logic "1"

b2, VPON (VPP ON) – VPON is a read-only bit and when at a logic "0" it indicates that a "high voltage" is present at the VPP pin

1 = no "high voltage" on Vpp pin

0="high voltage" on Vpp pin

VPON being "1" "disconnects" PGE and PLE from the rest of the chip, preventing accidental clearing of these bits from effecting the normal operating mode

Note

VPON being "0" does not indicate that the Vpp level is correct for programming. It is used as a safety interlock for the user in the normal operating mode.

The Programming Control Register functions are shown below

| VPON | PGE | PLE | Programming Conditions |
|------|-----|-----|---|
| 0 | 0 | 0 | Programming mode (program EPROM byte) |
| 1 | 0 | 0 | PGE and PLE disabled from system |
| 0 | 1 | 0 | Programming disabled (latch address and |
| | | | data in EPROM) |
| 1 | 1 | 0 | PGE and PLE disabled from system |
| 0 | 0 | 1 | Invalid state, PGE=0 iff PLE=0 |
| 1 | 0 | 1 | Invalid state, PGE=0 iff PLE=0 |
| 0 | 1 | 1 | "High voltage" on Vpp |
| 1 | 1 | 1 | PGE and PLE disabled from system |
| 1 | | | (Operating Mode) |
| | | 1 | |

ERASING THE EPROM

The MC68705R3 EPROM can be erased by exposure to high-intensity ultraviolet (UV) light with a wavelength of 2537 $\mathring{\mathbf{A}}$. The recommended integrated does (UV intensity x exposure time) is 15 Ws/cm². The lamps should be used without shortwave filters and the MC68705R3 should be positioned about one inch from the UV tubes. Ultraviolet erasure clears all bits of the MC68705R3 EPROM to the "0" state. Data is then entered by programming "1s" into the desired bit locations.

Caution

Be sure that the EPROM window is shielded from light except when erasing. This protects both the EPROM and light-sensitive nodes.

PROGRAMMING FIRMWARE

The MC68705R3 has 191 bytes of mask ROM containing a bootstrap program which can be used to program the

MC68705R3 EPROM The vector at addresses \$FF6 and \$FF7 is used to start executing the program. This vector is fetched when VIHTP is applied to pin 8 (TIMER/BOOT pin) of the MC68705R3 and the RESET pin is allowed to rise above VIRES + Figure 21 provides a schematic diagram of a circuit and a summary of programming steps which can be used to program the EPROM in the MC68705R3.

PROGRAMMING STEPS

The MCM2532 UV EPROM must first be programmed with an exact duplicate of the information that is to be transferred to the MC68705R3 Non-EPROM addresses are ignored by the bootstrap Since the MC68705R3 and the MCM2532 are to be inserted and removed from the circuit they should be mounted in sockets. In addition, the precaution below must be observed (refer to Figure 21)

MCM24332 into their respective sockets. This ensures that $\overline{\text{RESET}}$ is held low while inserting the devices. When ready to program the MC68705R3 it is only necessary to provide V_{CC} and \pm 26 V, open switch S2 (to

apply Vpp and VIHTP) and then open S1 (to remove Reset) Once the voltages are applied and both S2 and S1 are open, the CLEAR output control line (PBA) goes high and then low, then the 12-bit counter (MC14040B) is clocked by the PB3 output (COUNT). The counter selects the MCM2532 EPROM byte which is to load the equivalent MC68705R3 EPROM byte selected by the bootstrap program Once the PROM location is loaded, COUNT clocks the counter to the next EPROM location. This continues until the MC68705R3 is completely programmed at which time the Programmed indicator LED is lit. The counter is cleared and the loop is repeated to verify the programming is correct.

Once the MC68705R3 has been programmed and verified, close switch S2 (to remove Vpp and V_{IHTP}) and close switch S1 (to Reset) Disconnect +26 V and V_{CC}, then remove the MC68705R3 from its socket

MC6805R2 EMULATION

The MC68705R3 emulates the MC6805R2 "exactly" MC6805R2 mask features are implemented in the Mask Option Register (MOR) EPROM byte on the MC68705R3 There

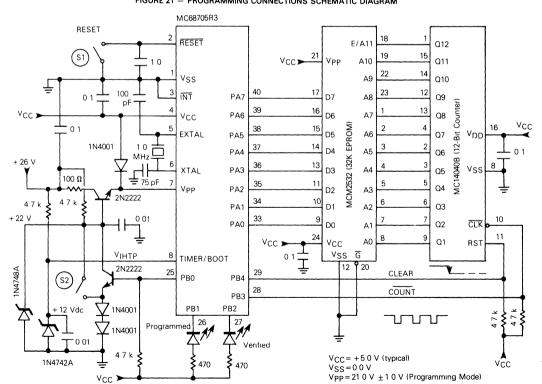


FIGURE 21 — PROGRAMMING CONNECTIONS SCHEMATIC DIAGRAM

Summary of Programming Steps

- 1 When plugging in the MC68705R3 or the MCM2532 be sure that S1 and S2 are closed and that V_{CC} and +26 V are not applied
- 2 To initiate programming, be sure S1 is closed, S2 is closed and V_{CC} and + 26 V are applied. Then open S2, followed by S1
- Before removing the MC68705R3, first close S2 and then close S1 Disconnect V_{CC} and +26 V then remove the MC68705R3.

are a few minor exceptions to the exactness of emulation which are listed below.

- The MC6805R2 "future ROM" area is implemented in the MC68705R3 and these 1728 bytes must be left unprogrammed to accurately simulate the MC6805R2. (The MC6805R2 reads all zeros from this area.)
- The reserved ROM areas in the MC6805R2 and MC68705R3 have different data stored in them and this data is subject to change without notice. The MC6805R2 uses the reserved ROM for the Self-Check feature and the MC68705R3 uses this area for the bootstrap program.
- The MC6805R2 reads all ones in its 48 byte "future RAM" area. This RAM is not implemented in the MC6805R2 mask ROM version, but is implemented in the MC68705R3
- The Vpp line (pin 7) in the MC68705R3 must be tied to V_{CC} for normal operation. In the MC6805R2, pin 7 is the NUM pin and is grounded in normal operation.
- 5 The LVI feature is not available in the MC68705R3 Processing differences are not presently compatible with proper design of this feature in the EPROM version.
- 6 The function in the Non-User Mode is not identical to the MC6805R2 version. Therefore, the MC68705R3 does not function in the MEX6805 Support System. In normal operation, all pin functions are the same as on the MC6805R2 version, except for pin 7 as previously noted.

The operation of all other circuitry has been exactly duplicated or designed to function exactly the same way in both devices including Interrupts, Timer, Data Ports, and Data Direction Registers (DDRs). A stated design goal has been to provide the user with a safe inexpensive way to verify his program and system design before committing to a factory programmed ROM.

SOFTWARE

BIT MANIPULATION

The MCU has the ability to set or clear any single random-access memory or input/output bit (except the Data Direction Register, see Caution under INPUT/OUTPUT paragraph), with a single instruction (BSET, BCLR). Any bit in the page zero memory can be tested, using the BRSET and BRCLR instructions, and the program branches as a result of its state. The Carry bit equals the value of the bit referenced by BRSET and BRCLR. A Rotate instruction may then be used to accumulate serial input data in a RAM loca-

tion or register. This capability to work with any bit in RAM, ROM, or I/O allows the user to have individual flags in RAM or to handle I/O bits as control lines. The coding example in Figure 22 illustrates the usefulness of the bit manipulation and test instructions. Assume that the MCU is to communicate with an external serial device. The external device has a data ready signal, a data output line, and a clock line to clock data one bit at a time, LSB first, out of the device. The MCU waits until the data is ready, clocks the external device, picks up the data in the Carry flage (C-bit), clears the clock line, and finally accumulates the data bit in a RAM location

ADDRESSING MODES

The MCU has 10 addressing modes which are explained briefly in the following paragraphs. For additional details and graphical illustrations, refer to the M6805 Family User Manual

The term "effective address" (EA) is used in describing the addressing modes. EA is defined as the address from which the argument for an instruction is fetched or stored.

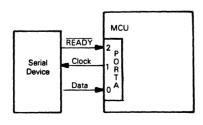
IMMEDIATE — In the immediate addressing mode, the operand is contained in the byte immediately following the opcode. The immediate addressing mode is used to access constants which do not change during program execution (e.g., a constant used to initialize a loop counter).

DIRECT — In the direct addressing mode, the effective address of the argument is contained in a single byte following the opcode byte. Direct addressing allows the user to directly address the lowest 256 bytes in memory with a single 2-byte instruction. This address area includes all on-chip RAM, I/O registers, and 128 bytes of EPROM. Direct addressing is an effective use of both memory and time.

EXTENDED — In the extended addressing mode, the effective address of the argument is contained in the two bytes following the opcode Instructions using extended addressing are capable of referencing arguments anywhere in memory with a single 3-byte instruction. When using the Motorola assembler, the programmer need not specify whether an instruction uses direct or extended addressing. The assembler automatically selects the shortest form of the instruction.

RELATIVE — The relative addressing mode is only used in branch instructions. In relative addressing, the contents of the 8-bit signed byte following the opcode (the offset) is added to the PC, if and only if, the branch condition is true. Otherwise, control proceeds to the next instruction. The

FIGURE 22 - BIT MANIPULATION EXAMPLE



SELF BRSET 2, PORTA, SELF

BSET 1, PORTA
BRCLR 0, PORTA, CONT
CONT BCLR 1, PORTA
ASR RAMLOC

span of relative addressing is from -126 to +129 from the opcode address. The programmer need not worry about calculating the correct offset when using the Motorola assembler, since it calculates the proper offset and checks to see if it is within the span of the branch

INDEXED, NO OFFSET — In the indexed, no offset addressing mode, the effective address of the argument is contained in the 8-bit index register. Thus, this addressing mode can access the first 256 memory locations. These instructions are only one byte long. This mode is often used to move a pointer through a table or to hold the address of a frequency referenced RAM or I/O location.

INDEXED, 8-BIT OFFSET — In the indexed, 8-bit offset addressing mode, the effective address is the sum of the contents of the unsigned 8-bit index register and unsigned byte following the opcode. This addressing mode is useful in selecting the kth element in an n element table. With this 2-byte instruction, k would typically be in X with the address of the beginning of the table in the instruction. As such tables may begin anywhere within the first 256 addressable locations and could extend as far as location 511 (81FE).

INDEXED, 16-BIT OFFSET — In the indexed, 16-bit offset addressing mode, the effective address is the sum of the contents of the unsigned 8-bit index register and the two unsigned bytes following the opcode. This address mode can be used in a manner similar to indexed, 8-bit offset, except that this 3-byte instruction allows tables to be anywhere in memory. As with Direct and Extended addressing, the Motorola assembler determines the shortest form of indexed addressing.

BIT SET/CLEAR — In the bit set/clear addressing mode, the bit to be set or cleared is part of the opcode and the byte following the opcode specifies the direct address of the byte in which the specified bit is to be set or cleared. Thus, any read/write bit in the first 256 locations of memory, including I/O, can be selectively set or cleared with a single 2-byte instruction. See Caution under the INPUT/OUTPUT paragraph.

BIT TEST AND BRANCH — The bit test and branch addressing mode is a combination of direct addressing and relative addressing. The bit which is to be tested and the condition (set or clear) is included in the opcode, and the address of the byte to be tested is in the single byte immediately following the opcode byte. The signed relative 8-bit offset is in the third byte and is added to the value of the PC, if the branch condition is true. This single 3-byte instruction allows the program to branch based on the condition of any readable bit in the first 256 locations of memory. The span of branching is from — 125 to + 130 from the opcode

address. The state of the tested bit is also transferred to the Carry bit of the Condition Code Register. See Caution under the INPUT/OUTPUT paragraph

INHERENT — In the inherent addressing mode, all the information necessary to execute the instruction is contained in the opcode. Operations specifying only the index register or accumulator, as well as control instruction with no other arguments, are included in this mode. These instructions are one byte long

INSTRUCTION SET

The MCU has a set of 59 basic instructions, which when combined with the 10 addressing modes produce 207 usable opcodes. They can be divided into five different types register/memory, read/modify/write, branch, bit manipulation, and control. The following paragraphs briefly explain each type. All the instructions within a given type are presented in individual tables.

REGISTERS/MEMORY INSTRUCTIONS — Most of these instructions use two operands. One operand is either the accumulator or the index register. The other operand is obtained from memory using one of the addressing modes. The jump unconditional (JMP) and jump to subroutine (JSR) instructions have no register operand. Refer to Table 3

READ/MODIFY/WRITE INSTRUCTIONS — These instructions read a memory location or a register, modify or test its contents, and write the modified value back to memory or to the register (see Caution under INPUT/OUT-PUT paragraph) The test for negative or zero (TST) instruction is included in the read/modify/write instructions, though it does not perform the write. Refer to Table 4.

BRANCH INSTRUCTIONS — The branch instructions cause a branch from the program when a certain condition is met. Refer to Table 5

BIT MANIPULATION INSTRUCTIONS — These instructions are used on any bit in the first 256 bytes of the memory (see Caution under INPUT/OUTPUT paragraph) One group either sets or clears The other group performs the bit test and branch operations Refer to Table 6.

CONTROL INSTRUCTIONS — The control instructions control the MCU operations during program execution Refer to Table 7

ALPHABETICAL LISTING — The complete instruction set is given in alphabetical order in Table 8

OPCODE MAP SUMMARY — Table 9 is an opcode map for the instructions used on the MCU.

TABLE 3 - REGISTER/MEMORY INSTRUCTIONS

| | | | | | | | | | A | ddressin | g Mode | es | | | | | | | |
|---|----------|------------|------------|-------------|------------|------------|-------------|------------|------------|-------------|------------------------|------------|-------------|---------------------------|------------|-------------|----------------------------|------------|-------------|
| | | | lmmed | ate | | Direct | | | Extend | ed | Indexed (No Offset) | | | Indexed (8-Bit Offset) | | | Indexed (16-Bit Offset) | | |
| Function | Mnemonic | Op Code | # Bytes | # Cycles | Op Code | # Bytes | # Cycles | Op Code | # Bytes | # Cycles | Op Code | # Bytes | # Cycles | Op Code | # Bytes | # Cycles | OP Code | # Bytes | # Cycles |
| Load A from Memory | LDA | A6 | 2 | 2 | B6 | 2 | 4 | C6 | 3 | 5 | F6 | 1 | 4 | E6 | 2 | 5 | D6 | 3 | 6 |
| Load X from Memory | LDX | AE | 2 | 2 | BE | 2 | 4 | CE | 3 | 5 | FE | 1 | 4 | EE | 2 | 5 | DE | 3 | 6 |
| Store A in Memory | STA | - | - | - | B7 | 2 | 5 | C7 | 3 | 6 | F7 | 1 | 5 | E7 | 2 | 6 | D7 | 3 | 7 |
| Store X in Memory | STX | _ | - | - | BF | 2 | 5 | CF | 3 | 6 | FF | 1 | 5 | EF | 2 | 6 | DF | 3 | 7 |
| Add Memory to A | ADD | AB | 2 | 2 | 88 | 2 | 4 | СВ | 3 | 5 | FB | 1 | 4 | EB | 2 | 5 | DB | 3 | 6 |
| Add Memory and Carry to A | ADC | Α9 | 2 | 2 | В9 | 2 | 4 | C9 | 3 | 5 | F9 | 1 | 4 | E9 | 2 | 5 | D9 | 3 | 6 |
| Subtract Memory | SUB | A0 | 2 | 2 | BO | 2 | 4 | CO | 3 | 5 | FO | 1 | 4 | EO | 2 | 5 | DO | 3 | 6 |
| Subtract Memory from A with Borrow | SBC | A2 | 2 | 2 | B2 | 2 | 4 | C2 | 3 | 5 | F2 | 1 | 4 | E2 | 2 | 5 | D2 | 3 | 6 |
| AND Memory to A | AND | A4 | 2 | 2 | B4 | 2 | 4 | C4 | 3 | 5 | F4 | 1 | 4 | E4 | 2 | 5 | D4 | 3 | 6 |
| OR Memory with A | ORA | AA | 2 | 2 | BA | 2 | 4 | CA | 3 | 5 | FA | 1 | 4 | EA | 2 | 5 | DA | 3 | 6 |
| Exclusive OR Memory with A | EOR | A8 | 2 | 2 | 88 | 2 | 4 | С8 | 3 | 5 | F8 | 1 | 4 | E8 | 2 | 5 | D8 | 3 | 6 |
| Arithmetic Compare A with Memory | СМР | Α1 | 2 | 2 | В1 | 2 | 4 | C1 | 3 | 5 | F1 | 1 | 4 | E1 | 2 | 5 | D1 | 3 | 6 |
| Arithmetic Compare X with Memory | СРХ | А3 | 2 | 2 | В3 | 2 | 4 | С3 | 3 | 5 | F3 | 1 | 4 | E3 | 2 | 5 | D3 | 3 | 6 |
| Bit Test Memory with A (Logical Compare) | BIT | A 5 | 2 | 2 | В5 | 2 | 4 | C5 | 3 | 5 | F5 | 1 | 4 | £5 | 2 | 5 | D5 | 3 | 6 |
| Jump Unconditional | JMP | _ | - | | BC | 2 | 3 | CC | 3 | 4 | FC | 1 | 3 | EC | 2 | 4 | DC | 3 | 5 |
| Jump to Subroutine | JSR | _ | - | - | BD | 2 | 7 | CD | 3 | 8 | FD | 1 | 7 | ED | 2 | 8 | DD | 3 | 9 |

TABLE 4 - READ/MODIFY/WRITE INSTRUCTION

| | | | Addressing Modes | | | | | | | | | | | | | |
|------------------------------|----------|------------|------------------|-------------|------------|------------|-------------|------------|------------|-------------|------------|------------|-------------|------------|------------|-------------|
| | | 11 | nheren | t (A) | 11 | nheren | t (X) | | Direc | et | (| Index | | (8 | Index | |
| Function | Mnemonic | Op Code | # Bytes | # Cycles | Op Code | # Bytes | # Cycles | Op Code | # Bytes | # Cycles | Op Code | # Bytes | # Cycles | Op Code | # Bytes | # Cycles |
| Increment | INC | 4C | 1 | 4 | 5C | 1 | 4 | 3C | 2 | 6 | 7C | 1 | 6 | 6C | 2 | 7 |
| Decrement | DEC | 4A | 1 | 4 | 5A | 1 | 4 | 3A | 2 | 6 | 7A | 1 | 6 | 6A | 2 | 7 |
| Clear | CLR | 4F | 1 | 4 | 5F | 1 | 4 | 3F | 2 | 6 | 7F | 1 | 6 | 6F | 2 | 7 |
| Complement | сом | 43 | 1 | 4 | 53 | 1 | 4 | 33 | 2 | 6 | 73 | 1 | 6 | 63 | 2 | 7 |
| Negate (2's Complement) | NEG | 40 | 1 | 4 | 50 | 1 | 4 | 30 | 2 | 6 | 70 | 1 | 6 | 60 | 2 | 7 |
| Rotate Left Thru Carry | ROL | 49 | 1 | 4 | 59 | 1 | 4 | 39 | 2 | 6 | 79 | 1 | 6 | 69 | 2 | 7 |
| Rotate Right Thru Carry | ROR | 46 | 1 | 4 | 56 | 1 | 4 | 36 | 2 | 6 | 76 | 1 | 6 | 66 | 2 | 7 |
| Logical Shift Left | LSL | 48 | 1 | 4 | 58 | 1 | 4 | 38 | 2 | 6 | 78 | 1 | 6 | 68 | 2 | 7 |
| Logical Shift Right | LSR | 44 | 1 | 4 | 54 | 1 | 4 | 34 | 2 | 6 | 74 | 1 | 6 | 64 | 2 | 7 |
| Arithmetic Shift Right | ASR | 47 | 1 | 4 | 57 | 1 | 4 | 37 | 2 | 6 | 77 | 1 | 6 | 67 | 2 | 7 |
| Test for Negative or Zero | TST | 4D | 1 | 4 | 5D | 1 | 4 | 3D | 2 | 6 | 7D | 1 | 6 | 6D | 2 | 7 |

TABLE 5 - BRANCH INSTRUCTIONS

| | | Relative | Address | ing Mode |
|--|----------|----------|---------|----------|
| | | Op | # | # |
| Function | Mnemonic | Code | Bytes | Cycles |
| Branch Always | BRA | 20 | 2 | 4 |
| Branch Never | BRN | 21 | 2 | 4 |
| Branch IFF Higher | вні | 22 | 2 | 4 |
| Branch IFF Lower or Same | BLS | 23 | 2 | 4 |
| Branch IFF Carry Clear | всс | 24 | 2 | 4 |
| (BranchIFFHigher or Same) | (BHS) | 24 | 2 | 4 |
| Branch IFF Carry Set | BCS | 25 | 2 | 4 |
| (BranchIFF Lower) | (BLO) | 25 | 2 | 4 |
| Branch IFF Not Equal | BNE | 26 | 2 | 4 |
| Branch IFF Equal | BEQ | 27 | 2 | 4 |
| Branch Half Carry Clear | внсс | 28 | 2 | 4 |
| Branch IFF Half Carry Set | BHCS | 29 | 2 | 4 |
| Branch IFF Plus | BPL | 2A | 2 | 4 |
| BranchIFF Minus | BMI | 2B | 2 | 4 |
| Branch IFF Interupt Mask Bit is Clear | вмс | 2C | 2 | 4 |
| Branch IFF Interrupt Mask Bit is Set | BMS | 2D | 2 | 4 |
| Branch IFF Interrupt Line is Low | BIL | 2E | 2 | 4 |
| Branch IFF Interrupt Line is High | ВІН | 2F | 2 | 4 |
| Branch to Subroutine | BSR | AD | 2 | 8 |

TABLE 6 - BIT MANIPULATION INSTRUCTIONS

| | | | | Addres | sing Mode | 3 | | |
|---------------------------|-------------------|-------------------------------------|------------|-------------|------------|------------|-------------|--|
| | | Bit Set / Clear Bit Test and Branch | | | | | | |
| Function | Mnemonic | Op Code | # Bytes | # Cycles | Op Code | # Bytes | # Cycles | |
| | | | Dytes | | 2 • n | | | |
| Branch IFF Bit n is set | BRSET n (n = 0 7) | | | | Z • n | 3 | 10 | |
| Branch IFF Bit n is clear | BRCLR n (n = 0 7) | - | - | - | 01 + 2 • n | 3 | 10 | |
| Set Bit n | BSET n (n = 0 7) | 10 + 2 • n | 2 | 7 | | _ | - | |
| Clear bit n | BCLR n (n = 0 7) | 11 + 2 • n | 2 | 7 | _ | | _ | |

TABLE 7 - CONTROL INSTRUCTIONS

| | | | Inherent | |
|--------------------------|----------|------|----------|--------|
| | | Op | # | # |
| Function | Mnemonic | Code | Bytes | Cycles |
| Transfer A to X | TAX | 97 | 1 | 2 |
| Transfer X to A | TXA | 9F | 1 | 2 |
| Set Carry Bit | SEC | 99 | 1 | 2 |
| Clear Carry Bit | CLC | 98 | 1 | 2 |
| Set Interrupt Mask Bit | SEI | 9B | 1 | 2 |
| Clear Interrupt Mask Bit | CLI | 9A | 1 | 2 |
| Software Interrupt | SWI | 83 | 1 | 11 |
| Return from Subroutine | RTS | 81 | 1 | 6 |
| Return from Interrupt | RTI | 80 | 1 | 9 |
| Reset Stack Pointer | RSP | 9C | 1 | 2 |
| No-Operation | NOP | 9D | 1 | 2 |

TABLE 8 - INSTRUCTION SET

| | Γ | | | | Addressin | g Modes | | | | | Co | ndi | tion | Codes | |
|----------|--------------|-----------|---------|----------|-----------|------------------------|---------------------|--|----------------------|--|----|-----|------|-------|---|
| Mnemonic | Inherent | Immediate | Direct | Extended | Relative | Indexed (No Offset) | Indexed (8 Bits) | Indexed (16 Bits) | Bit Set/ Clear | Bit Test & Branch | н | | N | z | С |
| ADC | · | X | × | X | | × | × | × | | | Λ | • | Λ | Λ | Λ |
| ADD | 1 | × | × | х | | × | × | × | | | Λ | • | + | Λ | Λ |
| AND | 1 | X | × | х | | × | × | × | | | • | • | Λ | Λ | • |
| ASL | × | | × | | | X | X | | | | • | • | Λ | Λ | Λ |
| ASR | × | | × | | | X | X | | | | • | • | Λ | Λ | Λ |
| BCC | † | | | | × | | | | | | • | • | • | • | • |
| BCLR | | | | | | | | | X | | • | • | • | • | • |
| BCS | | | | | × | | | | | | • | • | • | • | • |
| BEQ | ļ ——— | | | | × | | | | | | • | • | • | • | • |
| BHCC | † | | | | × | | | | | | • | • | • | • | • |
| BHCS | 1 | | | | × | | | | | | • | • | • | • | • |
| ВНІ | | | | | × | | | | | | • | • | • | • | • |
| BHS | 1 | | | | X | | | | | | • | • | • | • | • |
| BIH | 1 | | | | × | | | | | | • | • | | • | • |
| BIL | <u> </u> | | | | X | | | <u> </u> | | | • | • | • | • | • |
| BIT | 1 | Х | Х | X | | Х | X | X | | | • | • | Λ | Λ | • |
| BLO | | | | | Х | | | | | | • | • | • | • | • |
| BLS | | | | | X | | | | | | • | • | • | • | • |
| ВМС | | | | | × | | | | | | • | | • | • | • |
| ВМІ | | | | | Х | | | | | | • | • | • | • | • |
| BMS | 1 | | | | X | | | | | | • | • | | • | • |
| BNE | 1 | | | | X | | | † | <u> </u> | | • | • | • | • | • |
| BPL | 1 | | | 1 | Х | | | | | | • | • | • | • | • |
| BRA | | | | | Х | | | | | | • | • | • | • | • |
| BRN | | | | | X | | | | | | • | • | • | • | • |
| BRCLR | | | | | | | | | | X | • | • | • | • | Λ |
| BRSET | | | | | | | | | | X | • | | • | • | Λ |
| BSET | 1 | | | | | | | | X | | • | • | • | • | • |
| BSR | | | | | Х | | | | | | • | • | • | • | • |
| CLC | X | | | | | | | | | <u> </u> | • | • | • | • | 0 |
| CLI | X | | | | | | | | | | • | 0 | • | • | • |
| CLR | X | | × | | | X | × | | | | • | • | 0 | 1 | • |
| CMP | T | х | х | × | | × | × | X | | | • | • | Λ | Λ | Λ |
| СОМ | X | | × | | | X | × | | | | • | • | Λ | Λ | 1 |
| CPX | T | х | X | X | | х | X | X | | | • | | Λ | Λ | Λ |

Condition Code Symbols

- Half Carry (From Bit 3) Interrupt Mask
- N Z C A Negative (Sign Bit)
- Zero
- Carry/Borrow
- Test and Set if True, Cleared Otherwise
- Not Affected
- Load CC Register From Stack
- Set Clear

TABLE 8 - INSTRUCTION SET (CONTINUED)

| | T | | | | Addressin | Modes | | | | | Cor | ndit | tion | Co | des |
|----------|----------|-----------|--------|----------|-----------|------------------------|---------------------|----------------------|----------------------|-------------------------|-----|------|------|----|-----|
| Mnemonic | Inherent | Immediate | Direct | Extended | Relative | Indexed (No Offset) | Indexed (8 Bits) | Indexed (16 Bits) | Bit Set/ Clear | Bit Test & Branch | н | , | N | z | С |
| DEC | × | | X | | | X | Х | | | | • | • | Λ | Λ | • |
| EOR | | X | х | X | | X | х | × | | | • | • | Λ | Λ | • |
| INC | X | | X | | | X | X | | | | • | • | Λ | Λ | • |
| JMP | | | X | X | | × | Х | X | | | • | • | • | • | • |
| JSR | 1 | | X | X | | X | Х | X | | | • | • | • | • | • |
| LDA | | X | × | X | | X | X | X | | | • | • | Λ | Λ | • |
| LDX | | X | X | X | | Х | X | X | | | • | • | Λ | Λ | • |
| LSL | × | | × | | | Х | X | | | | • | • | Λ | Λ | Λ |
| LSR | X | | X | | | Х | X | | | | • | • | 0 | Λ | Λ |
| NEQ | X | | × | | | X | Х | | | | • | • | Λ | Λ | Λ |
| NOP | X | | | | | | | | | | • | • | • | • | • |
| ORA | 1 | X | X | X | | Х | X | X | | i | • | • | Λ | Λ | • |
| ROL | X | | X | | | X | Х | | | | • | • | Λ | Λ | Λ |
| RSP | X | | | | | | | 1 | | | • | • | • | • | • |
| RTI | X | | | | | | | | | | ? | 7 | ? | ? | 7 |
| RTS | X | | | | | | | | | | • | • | • | • | • |
| SBC | | X | X | X | | × | X | X | | | • | • | Λ | Λ | Λ |
| SEC | X | | | | | | | | | | • | • | • | • | 1 |
| SEI | X | | | | | | | | | l | • | 1 | • | • | • |
| STA | 1 | | X | X | | × | X | X | | | • | • | Λ | Λ | • |
| STX | | | X | X | | × | × | × | | | • | • | Λ | Λ | • |
| SUB | 1 | X | X | X | | X | X | X | | <u> </u> | • | • | Λ | Λ | Λ |
| SWI | X | | | | | | | | | | • | 1 | • | • | • |
| TAX | X | | | 1 | | | | | | | • | • | • | • | • |
| TST | X | | X | | | × | X | | | | • | • | Λ | Λ | • |
| TXA | X | | | | | | | | | | • | • | • | • | • |

Condition Code Symbols

- Half Carry (From Bit 3)
- Interrupt Mask
- Ν Negative (Sign Bit)
- Zero
- Carry/Borrow
- Test and Set if True, Cleared Otherwise
- Z C A Not Affected
- Load CC Register From Stack
- Set Clear

TABLE 9 - M6805 FAMILY INSTRUCTION SET OPCODE MAP

| | Bit Mar | nipulation | Branch | T | Re | ad/Modify/ | Write | | Cor | itrol | | | Registe | r/Memory | | | |
|-----------|-------------------------|----------------------------------|---------------------|---------------------|-----------------|----------------------|------------------|--------------------|-----------------------|---------------------|----------------|----------------|---------------------|---------------------|---------------------|---------------|-----------|
| | BTB | BSC | REL | DIR | INH(A) | INH(X) | IX1 | IX | INH | INH | IMM | DIR | EXT | IX2 | IX1 | IX | 1 |
| E V | 0000 | 0001 | 2 0010 | 3 0011 | 0100 | 5 0101 | 6 0110 | 7 0111 | 8 1000 | 9 1001 | A 1010 | B 1011 | C 1100 | D 1101 | E 1110 | F 1111 | Hi Low |
| 0000 | BRSETO BRSETO | BSET0 2 BSC | BRA 2 REL | 6 NEG 2 DIR | NEGA | NEGX | 7 NEG 2 IX1 | 6 NEG 1X | RTI 1 INH | | SUB 2 IMM | SUB 3 2 DIR | SUB 3 EXT | SUB 3 IX2 | SUB 2 IX1 | SUB 3 | 2000 |
| 1 0001 | BRCLRO BTB | BCLR0 2 BSC | BRN 2 REL | | | | | | 6 RTS | | CMP 2 IMM | CMP | 5 CMP 3 EXT | CMP 3 IX2 | 5 CMP 2 IX1 | CMP IX | 1 0001 |
| 2 0010 | BRSET1 3 BTB | BSET1 2 BSC | BHI 2 REL | | | | | | | | SBC 2 IMM | SBC DIR | SBC 3 EXT | SBC IX2 | SBC 4 | SBC 3 | 2 0010 |
| 3 0011 | BRCLR1 3 BTB | BCLR1 2 BSC | BLS 2 REL | 6 COM 2 DIR | COMA 1 INH | COMX 1 INH | COM 2 IX1 | 6 COM 5 | 11 10 SWI 1 INH | | 2 CPX 2 1MM | 4 CPX 2 DIR | 5 CPX 3 EXT | CPX 3 IX2 | CPX IX1 | 4 CPX 1 | 3 0011 |
| 4 0100 | BRSET2 3 BTB | BSET2 5 2 BSC | BCC REL | 6 LSR 2 DIR | 4 LSRA 1 INH | LSRX NH | 7 LSR 2 IX1 | 6 LSR 1 IX | | | 2 AND 2 | AND 2 DIR | AND 3 EXT | 6 AND 3 IX2 | AND IX1 | AND IX | 4 0100 |
| 5 0101 | 10 5 BRCLR2 3 BTB | BCLR2 5 2 BSC | BCS REL | | | | | | | | BIT 1 | 4 BIT 2 DIR | BIT 3 EXT | BIT X2 | BIT IX1 | BIT IX | 5 0101 |
| 6 0110 | BRSET3 3 BTB | BSET3 5 | 4 BNE 2 REL | 6 ROR 2 DIR | RORA 1 INH | 4 RORX 1 INH | ROR 2 IX1 | 6 ROR 1 | | | 2 LDA 2 IMM | | LDA 3 EXT | LDA 3 IX2 | LDA 2 IX1 | LDA IX | 6 0110 |
| 7 0111 | BRCLR3 3 BTB | BCLR3 2 BSC | 4 BEQ 2 REL | 6 ASR 2 DIR | 4 ASRA 1 INH | 4 3 ASRX 1 INH | 7 ASR 2 IX1 | 6 ASR 1 | | TAX | , | 5 STA 2 DIR | STA 3 EXT | 7 STA 3 IX2 | STA 2 IX1 | STA 1 | 7 0111 |
| 8 | BRSET4 3 BTB | BSET4 BSC BSC | BHCC REL | 6 LSL 2 DIR | 4 SLA 1 JNH | 4 SLX 1 INH | 7 LSL 2 IX1. | 6 LSL IX | | CLC 2 | EOR 2 | EOR DIR | 5 EOR 3 EXT | 6 EOR 5 | 5 EOR 2 IX1 | EOR IX | 8 1000 |
| 9 | BRCLR4 3 BTB | BCLR4 BSC | BHCS REL | 6 ROL 2 DIR | 4 ROLA 1 INH | 4 ROLX 1 INH | 7 ROL 2 IX1 | 6 ROL | | SEC 1 INH | ADC 2 | 4 ADC DIR | ADC | ADC 5 | 5 ADC 1X1 | 4 ADC | 9 1001 |
| A 1010 | BRSET5 | BSET5 2 BSC | BPL REL | 6 DEC 2 DIR | DECA 1 INH | DECX 1 INH | 7 DEC 2 IX1 | 6 DEC 5 | | CLI INH | ORA 2 IMM | ORA DIR | 5 ORA 3 EXT | 6 ORA 5 | ORA 2 IXI | ORA IX | A 1010 |
| B 1011 | BRCLR5 3 BTB | 7 BCLR5 2 BSC 7 5 | 4 BMI 2 REL | | | | | | | SEI 1 INH | 2 ADD 2 IMM | 4 ADD 2 DIR | 5 ADD 3 EXT | 6 ADD 5 | 5 ADD 2 1X1 | ADD IX | B 1011 |
| C 1100 | BRSET6 3 BTB | BSET6 2 BSC | BMC REL | 6 5 INC 2 DIR | INCA 1 INH | INCX I INH | INC IX1 | 6 INC 5 | | RSP INH | | JMP DIR | 4 JMP 3 EXT | 5 JMP 3 IX2 | 4 3 JMP 2 IX1 | JMP IX | C 1100 |
| D 1101 | BRCLR6 3 BTB | BCLR6 BSC | BMS REL | 6 TST 2 DIR | TSTA | 4 TSTX 1 INH | 7 TST 2 IX1 | 6 TST 1 IX | | 2 2 NOP 1 INH | B BSR 2 REL | 7 JSR 2 DIR | B 6 JSR 3 EXT | 9 7 JSR 3 IX2 | 8 6 JSR 2 IX1 | 7 JSR 1 IX | D 1101 |
| E 1110 | BRSET7 3 BTB | BSET7 BSC | 4 3 BIL 2 REL | | _ | | | | STOP 2 | | LDX 2 IMM | | LDX 3 EXT | 6 LDX 3 IX2 | LDX 2 IX1 | LDX 1 | E 1110 |
| F 1111 | BRCLR7 3 BTB | BCLR7 2 BSC | BIH REL | 6 5 CLR 2 DIR | 4 CLRA 1 INH | 4 3 CLRX 1 INH | 7 CLR 6 2 IX1 | 6 5 CLR 1 IX | WAIT 1 INH | 2 TXA 1 INH | | STX | 6 STX 3 EXT | 7 STX 6 3 IX2 | 6 STX 2 IX1 | STX 1 | F 1111 |

Abbreviations for Address Modes

INH Inherent IMM Immediate DIR Direct EXT Extended REL Relative BSC Bit Set/Clear BTB Bit Test and Branch Indexed (No Offset) IX Indexed, 1 Byte (8-Bit) Offset IX1 Indexed, 2 Byte (16-Bit) Offset IX2

of Cycles (HMOS Versions)

of Cycles (HMOS Versions)

4 SUB 3 O Opcode in Hexadecimal

of Cycles (CMOS Versions)

of Cycles (CMOS Versions)

Address Mode

LEGEND

*CMOS only



MC68705U3

Advance Information

8-BIT EPROM MICROCOMPUTER UNIT

The MC68705U3 Microcomputer Unit (MCU) is an EPROM member of the M6805 Family of low-cost single-chip microcomputers. The user programmable EPROM allows program changes and lower volume applications in comparison to the factory mask programmable versions. The EPROM versions also reduce the development costs and turnaround time for prototype evaluation of the mask ROM versions. This 8-bit microcomputer contains a CPU, on-chip CLOCK, EPROM, bootstrap ROM, RAM, I/O, and a TIMER

Because of these features, the MC68705U3 offers the user an economical means of designing the M6805 Family MCU into his system, either as a prototype evaluation, as a low-volume production run, or a pilot production run

A comparison of the key features for several members of the M6805 Family is shown on the last page of this data sheet

HARDWARE FEATURES:

- 8-Bit Architecture
- 112 Bytes of RAM
- Memory Mapped I/O
- 3776 Bytes of User EPROM
- Internal 8-Bit Timer with 7-Bit Prescaler
 - Programmable Prescaler
 - Programmable Timer Input Modes
- 4 Vectored Interrupts External (2), Timer (1), and Software (1)
- Zero-Cross Detection on INT Input
- 24 TTL/CMOS Compatible Bidirectional I/O Lines (8 Lines are LED Compatible)
- 8 Digital Input Lines
- On-Chip Clock Generator
- Master Reset
- Complete Development System Support on EXORciser®
- 5 V Single Supply
- Emulates the MC6805U2
- Bootstrap Program in ROM Simplifies EPROM Programming

SOFTWARE

- Similar to M6800 Family
- Byte Efficient Instruction Set
- Easy to Program
- True Bit Manipulation
- Bit Test and Branch Instructions
- Versatile Interrupt Handling
- Versatile Index Register
- Powerful Indexed Addressing for Tables
- Full Set of Conditional Branches
- Memory Usable as Registers/Flags
- Single Instruction Memory Examine/Change
- 10 Powerful Addressing Modes
- All Addressing Modes Apply to EPROM, RAM, and I/O

HMOS

(HIGH-DENSITY, N-CHANNEL DEPLETION LOAD, 5 V EPROM PROCESS)

8-BIT EPROM MICROCOMPUTER

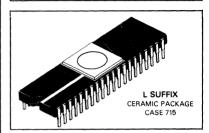
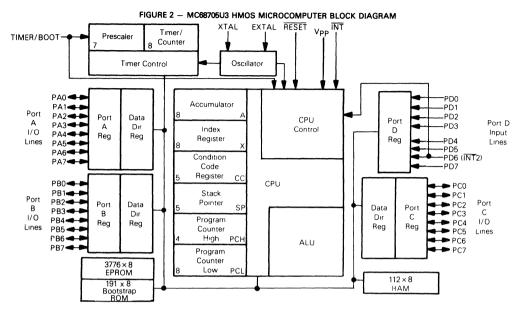


FIGURE 1 - PIN ASSIGNMENTS

| Vss £ 1 ● | 40 1 PA7 |
|----------------------|-----------------|
| RESET 1 2 | 39 1 PA6 |
| INT 🛛 3 | 38 1 PA5 |
| Vcc t 4 | 37 D PA4 |
| EXTAL [5 | 36 D PA3 |
| XTAL 6 | 35 † PA2 |
| VPP [] 7 | 34 1 PA1 |
| TIMER/BOOT 6 | 33 J PA0 |
| PC0 [9 | 32 1 PB7 |
| PC1 [10 | 31 1 PB6 |
| PC2 [11 | 30 1 PB4 |
| PC3 [12 | 29 1 PB5 |
| PC4 [13 | 28 🕽 PB3 |
| PC5 [14 | 27 1 PB2 |
| PC6 [15 | 26 🗖 PB1 |
| PC7 16 | 25 1 PB0 |
| PD7 D 17 | 24 🗖 PD0 |
| PD6/INT2 [18 | 23 1 PD1 |
| PD5 [19 | 22 1 PD2 |
| PD4 [] 20 | 21 D PD3 |
| | |



MAXIMUM RATINGS

| Rating | Symbol | Value | Unit |
|--|-------------------|---------------|------|
| Supply Voltage | V _{CC} | -03 to +70 | ٧ |
| Input Voltage EPROM Programming Voltage (Vpp Pin) TIMER/BOOT Pin | Vpp | -0 3 to +22 0 | ٧ |
| Normal Mode | V _{in} | -03 to +70 | V |
| Bootstrap Programming Mode | V _{ВООТ} | -30 to +150 | V |
| All Others | V _{in} | -03 to +70 | ٧ |
| Operating Temperature Range | TA | 0 to +50 | °C |
| Storage Temperature Range | T _{stg} | -55 to +150 | °C |
| Junction Temperature | ΤJ | + 150 | °C |

This device contains circuitry to protect the inputs against damage due to high static voltages or electric fields, however, it is advised that normal precautions be taken to avoid application of any voltage higher than maximum rated voltages to this high-impedance circuit. For proper operation it is recommended that V_{in} and V_{out} be constrained to the range $V_{SS} \leq (V_{in}$ or $V_{out}) \leq V_{CC}$. Reliability of operation is enhanced if unused inputs are tied to an appropriate logic voltage level (e.g., either V_{SS} or V_{CC})

(3)

THERMAL CHARACTERISTICS

| Characteristic | Symbol | Value | Unit |
|--------------------|---------------|-------|------|
| Thermal Resistance | | | |
| Ceramic Package | θ_{JA} | 50 | °C/W |

POWER CONSIDERATIONS

The average chip-junction temperature, TJ, in °C can be obtained from

$$T_{J} = T_{A} + (P_{D} \bullet \theta_{JA})$$
Where:

T_A ≡ Ambient Temperature, °C

 $\theta_{JA} = Package Thermal Resistance, Junction-to-Ambient, °C/W$

PD≡PINT+PPORT

PINT = ICC= VCC, Watts - Chip Internal Power

·PPORT≡Port Power Dissipation, Watts - User Determined

For most applications $PPORT \blacktriangleleft PINT$ and can be neglected PPORT may become significant if the device is configured to drive Darlington bases or sink LED loads

An approximate relationship between PD and TJ (if PPORT is neglected) is

$$P_D = K + (T_1 + 273 ^{\circ}C)$$
 (2)

Solving equations 1 and 2 for K gives.

$$K = PD \bullet (TA + 273 \circ C) + \theta JA \bullet PD^2$$

Where K is a constant pertaining to the particular part. K can be determined from equation 3 by measuring P_D (at equilibrium) for a known T_A . Using this value of K the values of P_D and T_J can be obtained by solving equations (1) and (2) iteratively for any value of T_A .

PROGRAMMING OPERATION ELECTRICAL CHARACTERISTICS

 $(V_{CC} = 5.25 \text{ Vdc } \pm 0.5, V_{SS} = \text{GND}, T_A = 20^{\circ} \text{ to } 30^{\circ}\text{C} \text{ unless otherwise noted})$

| Characteristic | Symbol | Min | Тур | Max | Unit |
|--|--------|------|------|---------|------|
| Programming Voltage | VPP | 20 0 | 21 0 | 22 0 | ٧ |
| Vpp Supply Current Vpp = 5 25 V Vpp = 21 0 V | lpp | _ | _ | 8 30 | mA |
| Oscillator Frequency | foscp | 09 | 10 | 11 | MHz |
| Bootstrap Programming Mode Voltage (TIMER/BOOT Pin) (@ I _{1HTP} = 100 µA Max) | VIHTP | 90 | 12 0 | 15 0 | ٧ |

SWITCHING CHARACTERISTICS (V_{CC}= +5 25 Vdc ±0 5 V, V_{SS} = GND, T_A=0° to 50°C unless otherwise noted)

| Characteristic | Symbol | Min | Тур | Max | Unit | |
|--|------------------|------------------------|-----|-----|------|--|
| Oscillator Frequency | | | | | | |
| Normal | fosc | 0 4 | - | 4 2 | MHz | |
| Instruction Cycle Time (4/f _{OSC}) | tcyc | 0 950 | - | 10 | μS | |
| INT, INT2, or Timer Pulse Width | tWL, tWH | t _{CyC} + 250 | _ | - | ns | |
| RESET Pulse Width | tRWL | t _{CyC} + 250 | _ | - | ns | |
| RESET Delay Time (External Cap = 1 0 μF) | t _{RHL} | 100 | _ | _ | ms | |
| INT Zero Crossing Detection Input Frequency (for ±5° Accuracy) | fINT | 0 03 | | 10 | kHz | |
| External Clock Duty Cycle (EXTAL) (See Figure 12) | | 40 | 50 | 60 | % | |

DC ELECTRICAL CHARACTERISTICS (V_{CC} = +5 25 Vdc \pm 0 5 Vdc, V_{SS} = GND, T_A = 0 $^{\circ}$ to 50 $^{\circ}$ C unless otherwise noted)

| Characteristic | Symbol | Mın | Тур | Max | Unit |
|---|-------------------|--|-------------------------|----------------------------------|------|
| Input High Voltage RESET (4 75≤V _{CC} ≤5 75) (V _{CC} <4 75) INT (4 75≤V _{CC} ≤5 75) (V _{CC} <4 75) All Other | V _{IH} | 40 V _{CC} -05 40 V _{CC} -05 20 | - - ** ** | Vcc Vcc Vcc Vcc Vcc | ٧ |
| Input High Voltage (TIMER/BOOT Pin) Timer Mode Bootstrap Programming Mode | V _{IH} | 2 0 9 0 | _ 12 0 | V _{CC} 15 0 | ٧ |
| Input Low Voltage RESET INT All Other | VIL | -03 -03 -03 | - ** | 0 8 1 5 0 8 | ٧ |
| Internal Power Dissipation (No Port Loading, V _{CC} = 5 25 V, T _A = 0 °C) | PINT | _ | 600 | TBD | mW |
| Input Capacitance EXTAL All Other | C _{in} | _ _ | 25 10 | _ | pF |
| RESET Hysteresis Voltage (See Figure 11) Out of Reset Voltage Into Reset Voltage | VIRES+ VIRES- | 2 1 0 8 | _ | 4 0 2 0 | ٧ |
| Programming Voltage (Vpp Pin) Programming EPROM Operating Mode | V _{PP} * | 20 0 4 0 | 21 0 V _{CC} | 22 0 5 75 | ٧ |
| Input Current TIMER (V_{In} = 0.4 V) INT (V_{In} = 0.4 V) EXTAL (V_{In} = 2.4 V to V_{CC} Crystal Option) (V_{In} = 0.4 V Crystal Option) RESET (V_{In} = 0.8 V) (External Capacitor Changing Current) | l _{in} | - - - - -40 | 20 | 20 50 10 - 1600 - 50 | μΑ |

^{*} Vpp is Pin 7 on the MC68705U3 and is connected to V_{CC} in the Normal Operating Mode. In the MC68705U3, Pin 7 is NUM and is connected to V_{SS} in the Normal Operating Mode. The user must allow for this difference when emulating the MC68705U3 ROM-based MCU.

^{* *} Due to internal biasing, this input (when not used) floats to approximately 2 0 V $\,$

PORT ELECTRICAL CHARACTERISTICS (V_{CC} = +5 25 Vdc ± 0.5 Vdc, V_{SS} = GND, T_A = 0° to 50°C unless otherwise noted)

| Characteristic | Symbol | Min | Тур | Max | Unit |
|--|------------------|-----|-----|------|------|
| Poi | rt A | | | | |
| Output Low Voltage, I _{Load} =16 mA | V _{OL} | - | | 04 | ٧ |
| Output High Voltage, I _{Load} = -100 μA | ∨он | 2 4 | - | - | ٧ |
| Output High Voltage, I _{Load} = -10 μA | VoH | 35 | _ | _ | V |
| Input High Voltage, $I_{Load} = -300 \mu A$ (Max) | V _{IH} | 20 | _ | Vcc | ٧ |
| Input Low Voltage, $I_{Load} = -500 \mu\text{A}$ (Max) | V _{IL} | -03 | _ | 0.8 | V |
| Hi-Z State Input Current (V _{In} = 2 0 V to V _{CC}) | liн | _ | - | -300 | μΑ |
| Hi-Z State Input Current (V _{IN} = 0.4 V) | իլ | _ | | -500 | μА |
| Por | t B | | | | |
| Output Low Voltage, ILoad=32 mA | VoL | _ | _ | 0 4 | ٧ |
| Output Low Voltage, ILoad = 10 mA (Sink) | V _{OL} | _ | _ | 10 | V |
| Output High Voltage, I _{Load} = -200 μA | VOH | 2 4 | _ | | V |
| Darlington Current Drive (Source), V _O = 1 5 V | І ОН | -10 | - | - 10 | mA |
| Input High Voltage | V _{IH} | 20 | | VCC | V |
| Input Low Voltage | VIL | -03 | _ | 0.8 | V |
| Hı-Z State Input Current | ^I TSI | _ | 2 | 20 | μА |
| | t C | | | | |
| Output Low Voltage, I _{Load} = 1 6 mA | V _{OL} | | _ | 0 4 | V |
| Output High Voltage, I _{Load} = -100 μA | Voн | 2 4 | | | V |
| Input High Voltage | VIH | 2 0 | _ | Vcc | V |
| Input Low Voltage | VIL | -03 | _ | 0.8 | V |
| Hi-Z State Input Current | ^I TSI | _ | 2 | 20 | μΑ |
| Port D (In | put Only) | | | | |
| Input High Voltage | VIH | 20 | - | Vcc | V |
| Input Low Voltage | V _{IL} | -03 | _ | 0.8 | V |
| Input Current* | l _{in} | - | _ | 20 | μΑ |

^{*} The A/D conversion resistor (nominal 11.5 k Ω) is connected internally between PD5/VRH and PD4/VRL

FIGURE 3 — TTL EQUIVALENT TEST LOAD (PORT B)

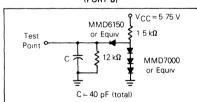


FIGURE 4 — CMOS EQUIVALENT TEST LOAD (PORT A)

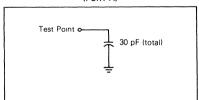
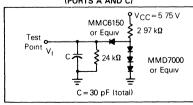


FIGURE 5 — TTL EQUIVALENT TEST LOAD (PORTS A AND C)



SIGNAL DESCRIPTION

The input and output signals for the MCU, shown in Figure 1, are described in the following paragraphs

V_{CC} and **V_{SS}** — Power is supplied to the MCU using two pins. **V_{CC}** is power and **V_{SS}** is the ground connection.

INT — This pin allows an external event to asynchronously interrupt the processor. It can also be used as a polled input using the BIL and BIH instructions. Refer to INTERRUPTS for additional information.

XTAL and EXTAL — These pins provide connections to the on-chip clock oscillator circuit. A crystal, a resistor, or an external signal, depending on the CLK bit (see MASK OPTIONS), is connected to these pins to provide a system clock source with various stability/cost tradeoffs. Lead lengths and stray capacitance on these two pins should be minimized. Refer to INTERNAL CLOCK GENERATOR OPTIONS for recommendations about these inputs.

TIMER/BOOT — This pin is used as an external input to control the internal timer/circuitry. This pin also detects a higher voltage level used to initiate the bootstrap program (see PROGRAMMING FIRMWARE). Refer to TIMER for additional information about the timer circuitry.

RESET — This pin has a Schmitt Trigger input and an onchip pullup. The MCU can be reset by pulling **RESET** low Refer to RESETS for additional information.

 \mbox{Vpp} — This pin is used when programming the EPROM By applying the programming voltage to this pin, one of the requirements is met for programming the EPROM. In normal operation, this pin is connected to \mbox{V}_{CC} Refer to PROGRAMMING. FIRMWARE and ELECTRICAL CHARACTERISTICS

INPUT/OUTPUT LINES (PA0-PA7, PB0-PB7, PC0-PC7,

PD0-PD7) — These 32 lines are arranged into four 8-bit ports (A, B, C, and D) Ports A, B, and C are programmable as either inputs or outputs, under software control of the Data Direction Register (DDRs) Port D is for digital input only and PD6 may be used for a second interrupt, INT2 Refer to IN-PUT/OUTPUT and INTERRUPTS paragraphs for additional information, being sure to observe the Caution

MEMORY

As shown in Figure 6, the MCU is capable of addressing 4091 bytes of memory and I/O registers with its program counter The MC68705U3 MCU has inplemented 4091 bytes of these locations. This consists of 3776 bytes of user EPROM, 191 bytes of bootstrap ROM, 112 bytes of user RAM, an EPROM Mask Option Register (MOR), a Program Control Register (PCR), seven bytes of I/O, two Timer Registers, and a Miscellaneous Register. The user EPROM is located in two areas. The main EPROM area is memory locations \$080 to \$F37 The second area is reserved for eight interrupt/reset vector bytes at memory locations \$FF8 to \$FFF The MCU uses 11 of the lowest 16 memory locations for program control and I/O features such as ports, the port DDRs, and the timer The Mask Option Register at memory location \$F38 completes the total The 112 bytes of user RAM include up to 31 bytes for the stack

The stack area is used during the processing of interrupt and subroutine calls to save the processor state. The contents of the MCU registers are pushed onto the stack in the order shown in Figure 7. Since the Stack Pointer decrements during pushes, the low order byte (PCL) of the Program Counter is stacked first, then the higher order four bits (PCH) are stacked. This ensures that the program counter is loaded correctly as the stack pointer increments when it pulls data from the stack. A subroutine call causes only the Program Counter (PCL, PCH) contents to be pushed onto the stack, the remaining CPU registers are not pushed.

6 5 4 3 2 I/O Ports Timer \$000 \$000 Port A Data and Port B Data \$001 Page Zero RAM Access With (128 Bytes) Port C Data \$002 \$07F 127 Short 128 ടവജവ Port D Data \$003 Page Zero Instructions User EPROM Port A DDR* \$004 (128 Bytes) 255 \$OFF Port B DDR* SOOS \$100 Port C DDR * \$006 Not Used \$007 User Main SOOR ρ Timer Data Reg **EPROM** (3640 Bytes) Timer Control Reg 9 \$009 10 Misc Reg \$00A 3895 \$F37 11 Program Control Reg \$00B Mask Option Reg 3896 \$F38 12 Not Used 3897 \$F39 \$00C-00F Bootstrap 15 ROM 16 \$010 (191 Bytes) 4087 SFF7 RAM 4088 \$FF8 (112 Bytes) Interrupt Stack Vectors

(8 Bytes)

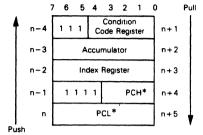
4095

FIGURE 6 - MC68705U3 MCU MEMORY CONFIGURATION

* CAUTION Data Direction Registers (DDRs) are write-only, they read as \$FF

(31 Bytes Maximum)

FIGURE 7 - INTERRUPT STACKING ORDER



* For subroutine calls, only PCH and PCL are stacked

CENTRAL PROCESSING UNIT

The CPU of the M6805 Family is implemented independently from the I/O or memory configuration. Consequently, it can be treated as an independent central processor communicating with I/O and memory via internal address, data, and control buses.

REGISTERS

The M6805 Family CPU has five registers available to the programmer. They are shown in Figure 8 and are explained in the following paragraphs.

ACCUMULATOR (A) — The accumulator is a general purpose 8-bit register used to hold operands and results of the arithmetic calculations or data manipulations

INDEX REGISTER (X) — The index register is an 8-bit register used for the indexed addressing mode. It contains an 8-bit value that may be added to an instruction value to create an effective address. The index register may also be used as a temporary storage area.

PROGRAM COUNTER (PC) — The program counter is a 12-bit register that contains the address of the next instruction to be executed

STACK POINTER (SP) — The stack pointer is a 12-bit register that contains the address of the next free location on the stack. During an MCU reset or the Reset Stack Pointer (RSP) instruction, the stack pointer is set to location \$07F. The stack pointer is then decremented as data is pushed onto the stack and incremented as data is then pulled from the stack. The seven most-significant bits of the stack pointer are permanently set to 0000011. Subroutines and interrupts may be nested down to location \$061 (31 bytes maximum), which allows the programmer to use up to 15 levels of subroutine calls (less if interrupts are allowed).

CONDITION CODE REGISTER (CC) — The condition code register is a 5-bit register in which four bits are used to indicate the results of the instruction just executed. These bits can be individually tested by a program and specific action taken as a result of their state. Each of the five bits is explained below.

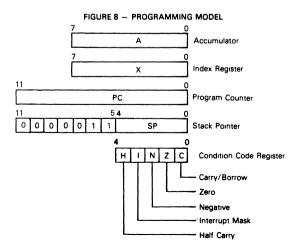
Half Carry (H) — Set during ADD and ADC operations to indicate that a carry occurred between bits 3 and 4

Interrupt (I) — When this bit is set the timer and external interrupt ($\overline{\text{INT}}$) are masked (disabled). If an interrupt occurs while this bit is set, the interrupt is latched and is processed as soon as the interrupt bit is cleared.

Negative (N) — When set, this bit indicates that the result of the last arithmetic, logical, or data manipulation was negative (bit 7 in the result is a logical one)

Zero (Z) — When set, this bit indicates that the result of the last arithmetic, logical, or data manipulation was zero

Carry/Borrow (C) — When set, this bit indicates that a carry or borrow out of the arithmetic logic unit (ALU) occurred during the last arithmetic operation. This bit is also affected during bit test and branch instructions plus shifts and rotates.



TIMER

The MC68705U3 MCU timer consists of an 8-bit software programmable counter which is driven by a 7-bit prescaler with selectable taps. Various timer clock sources may be selected ahead of the prescaler and counter. The timer selections are made via the Timer Control Register (TCR) and/or the Mask Option Register (MOR). The TCR also contains the interrupt control bits. The sections elsewhere entitled TIMER CONTROL REGISTER and MASK OPTIONS include additional details on controlling this timer.

The MCU timer circuitry is shown in Figure 9. The 8-bit counter may be loaded under program control and is decremented toward zero by the fCIN counter input (output of the prescaler option selection) Once the 8-bit counter has decremented to zero, it sets the TIR (Timer Interrupt Request) bit 7 (b7 of TCR) The TIM (Timer Interrupt Mask) bit (b6) can be software set to inhibit the interrupt request, or software cleared to pass the interrupt request to the processor When the I-bit in the Condition Code Register is cleared, the processor receives the Timer Interrupt. The CPU responds to this interrupt by saving the present CPU state on the stack, fetching the timer interrupt vector from locations \$FF8 and \$FF9 and executing the interrupt routine. The processor is sensitive to the level of the timer interrupt request line, therefore if the interrupt is masked, the TIR bit may be cleared by software (e.g., BCLR) without generating an interrupt. The TIR bit MUST be cleared, by the timer interrupt service routine, to clear the timer interrupt register

The timer interrupt and INT2 share the same interrupt vector. The interrupt routine thus must check the two request bits to determine the source of the interrupt.

The counter continues to count (decrement) after falling through to \$FF from zero. Thus, the counter can be read at any time by the processor without disturbing the count. This allows a program to determine the length of time since the occurrence of a timer interrupt and does not disturb the counting process.

The clock input to the timer can be from an external source (decrementing the counter occurs on a positive transition of the external source) applied to the TIMER input pin, or it can be the internal $\phi 2$ signal. When the $\phi 2$ signal is used as the source, it can be gated by an input applied to the TIMER pin allowing the user to easily perform pulse-width measurements (Note When the MOR TOPT bit is set and the CLS bit is clear, an ungated $\phi 2$ clock input is obtained by tying the TIMER pin to VCC) The source of the clock input is selected via the TCR or the MOR as described later

A prescaler option can be applied to the clock input that extends the timing interval up to a maximum of 128 counts before decrementing the counter. This prescaling TCR or MOR option selects one of eight taps on the 7-bit binary divider, the eighth tap bypasses prescaling. To avoid truncation errors, the prescaler is cleared when bit b3 of the TCR is written to a logic 1. TCR bit b3 always reads as a logic 0 to ensure proper operation with read/modify/write instructions (bit set and clear for example).

At Reset, the prescaler and counter are initialized to an all "1s" condition, the Timer Interrupt Request bit (TCR, b7) is cleared and the Timer Interrupt Request mask (TCR, b6) is set TCR b0 through b5 are initialized by the corresponding Mask Option Register (MOR) bits at Reset. They are then software selectable after Reset.

Note that the timer block diagram in Figure 9 reflects two separate timer control configurations, a) software controlled mode via the Timer Control Register (TCR), and b) MOR controlled mode to emulate a mask ROM version with the Mask Option Register. In the software controlled mode, all

TCR bits are read/write, except bit b3 which is write-only (always reads as a logic "0"). In the MOR controlled mode, TCR bits b7 and b6 are read/write, bit b3 is write-only, and the other five have no effect on a write and read as logic "1s". The two configurations provide the user with the capability to freely select timer options as well as accurately emulate the MC6805R2 mask ROM version. In the following paragraphs refer to Figure 9 as well as the TIMER CONTROL REGISTER and MASK OPTIONS sections

The TOPT (Timer Option) bit (b6) in the Mask Option Register is EPROM programmed to a logical "0" to select the software controlled mode, which is described first. TCR bits b5, b4, b3, b2, b1, and b0 give the program direct control of the prescaler and input selection options

The Timer Prescaler input (fpIN) can be configured for three different operating modes, plus a disable mode, depending upon the value written to TCR, control bits b4 and b5 (TIE and TIN) Refer to TIMER CONTROL REGISTER section

When the TIE and TIN bits are programmed to "0", the timer input is from the internal clock (ϕ 2) and TIMER input pin is disabled. The internal clock mode can be used for periodic interrupt generation as well as a reference for frequency and event measurement.

When TIE=1 and TIN=0, the internal clock and the TIMER input pin signals are ANDed to form the timer input This mode can be used to measure external pulse widths. The external pulse simply gates to the internal clock for the duration of the pulse. The accuracy of the count in this mode is \pm one count

When TIE=0 and TIN=1, no fp $_{\mbox{\scriptsize IN}}$ input is applied to the prescaler and the timer is disabled

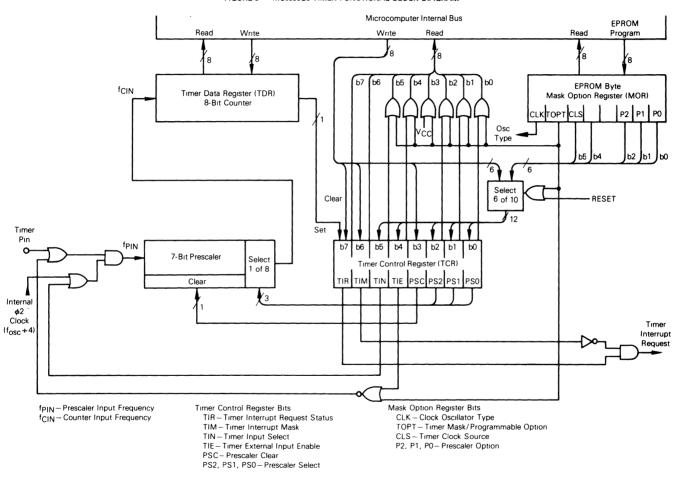
When TIE and TIN are both programmed to a "1", the timer is from the external clock. The external clock can be used to count external events as well as provide an external frequency for generating periodic interrupts.

Bits b0, b1, and b2 in the TCR are program controlled to choose the appropriate prescaler output. The prescaling divides the fpIN frequency by 1, 2, 4, etc. in binary multiples to 128 producing fcIN frequency to the counter. The processor cannot write into or read from the prescaler, however, the prescaler is set to all "1s" by a write operation to TCR, b3 (when bit 3 of the written data equals "1"), which allows for truncation-free counting.

The MOR controlled mode of the timer is selected when the TOPT (Timer Option) bit (b6) in the MOR is programmed to a logical "1" to emulate the MC6805R2 mask-programmable prescaler. The timer circuits are the same as described above, however, the Timer Control Register (TCR) is configured differently, as discussed below.

The logical level for the functions of bits b0, b1, b2, and b5 in the TCR are all determined at the time of EPROM programming They are controlled by corresponding bits within the Mask Option Register (MOR, \$F38) The value programmed into MOR bits b0, b1, b2, and b5 controls the prescaler division and the timer clock selection. Bit b4 (TIE) is set to a logical "1" in the MOR controlled mode. (When read by software, these five TCR bits always read as logical "1s") As in the software programmable configuration, the TIM (b6) and TIR (b7) bits of the TCR are controlled by the counter and software as described above and in the TIMER CONTROL REGISTER section. Bit b3 of the TCR, in the MOR controlled mode, always reads as a logical "0" and can be written to a logical "1" to clear the prescaler The MOR controlled mode is designed to exactly emulate the MC6805R2 which has only TIM, TIR, and PSC in the TCR and has the prescaler options defined as manufacturing mask options.

FIGURE 9 - MC6805U3 TIMER FUNCTIONAL BLOCK DIAGRAM



NOTE The TOPT bit in the Mask Option Register selects whether the timer is software programmable via the Timer Control Register or emulates the mask programmable ports via the MOR PROM byte

RESETS

The MCU can be reset in two ways by initial power-up, and by the external reset input (RESET). Upon power-up, a delay of t_{RHL} is needed before allowing the RESET input to go high. This time allows the internal clock generator to stabilize. Connecting a capacitor to the RESET input, as shown in Figure 10, typically provides sufficient delay.

The internal circuit connected to the RESET pin consists of a Schmitt trigger which senses the RESET line logic level. The Schmitt trigger provides an internal reset voltage when it senses logical "0" on the RESET pin During power-up, the Schmitt trigger switches on (removes reset) when the RESET pin voltage rises to VIRES + When the RESET pin voltage falls to a logical "0" for a period longer than one toyo, the Schmitt trigger switches off to provide an internal reset voltage. The "switch off" voltage occurs at VIRES - A typical reset Schmitt trigger hysteresis curve is shown in Figure 11. See Figure 15 for the complete reset sequence.

INTERNAL CLOCK GENERATOR OPTIONS

The internal clock generator circuit is designed to require a minimum of external components. A crystal, a resistor, a jumper wire, or an external signal may be used to generate a system clock with various stability/cost tradeoffs. The Mask Option Register (EPROM) is programmed to select crystal resistor operation. The oscillator frequency is internally divided by four to produce the internal system clocks.

The different connection methods are shown in Figure 12

FIGURE 10 - POWER-UP RESET DELAY CIRCUIT

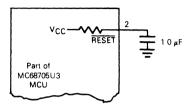


FIGURE 11 — TYPICAL RESET SCHMITT TRIGGER HYSTERESIS

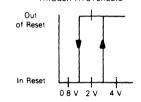
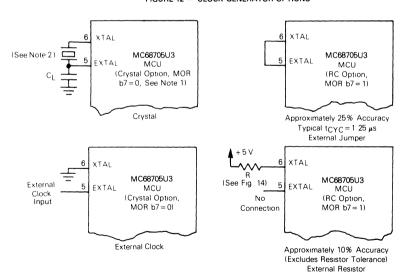


FIGURE 12 — CLOCK GENERATOR OPTIONS



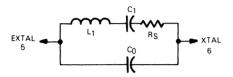
NOTE: 1 When the TIMER/BOOT input pin is in the V_{IHTP} range (in the bootstrap EPROM programming mode), the crystal option is forced. When the TIMER/BOOT input is at or below V_{CC}, the clock generator option is determined by bit 7 of the Mask Option Register (CLK)

2 The recommended C_L value with a 4 0 MHz crystal is 27 pF maximum, including system distributed capacitance. There is an internal capacitance of approximately 25 pF on the XTAL pin. For crystal frequencies other than 4 MHz, the total capacitance on each pin should be scaled as the inverse of the frequency ratio. For example, with a 2 MHz crystal, use approximately 50 pF on EXTAL and approximately 25 pF on XTAL. The exact value depends on the Motional-Arm parameters of the crystal used.

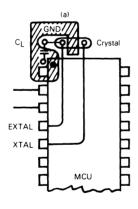
Crystal specifications are given in Figure 13. A resistor selection graph is given in Figure 14.

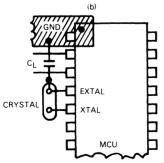
The crystal oscillator start-up time is a function of many variables: crystal parameters (especially R_{S}), oscillator load capacitances, IC parameters, ambient temperature, and supply voltage. To ensure rapid oscillator start-up neither the crystal characteristics nor the load capacitances should exceed recommendations

FIGURE 13 — CRYSTAL MOTIONAL-ARM PARAMETERS AND SUGGESTED PC BOARD LAYOUT



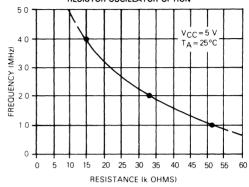
AT — Cut Parallel Resonance Crystal C_0 = 7 pF Max FREQ = 4 0 MHz @ C_L = 27 pF R_S = 100 ohms Max





Note Keep crystal leads and circuit connections as short as possible

FIGURE 14 — TYPICAL FREQUENCY SELECTION FOR RESISTOR OSCILLATOR OPTION



BOOTSTRAP ROM

The bootstrap ROM contains a factory program which allows the MCU to fetch data from an external device and transfer it into the MC68705U3 EPROM. The bootstrap program provides timing of programming pulses, timing of Vpp input, and verification after programming. See PROGRAMMING FIRMWARE section.

MASK OPTION REGISTER (MOR)

The Mask Option Register is an 8-bit user programmed (EPROM) register in which six of the bits are used. Bits in this register are used to select the type of system clock, the timer option, the timer/prescaler clock source, and the prescaler option. It is fully described in the MASK OPTIONS section.

INTERRUPTS

The MC68705U3 MCU can be interrupted four different ways through the external interrupt (INT) input pin, the internal timer interrupt request, the external Port C bit 6 (INT2) input pin, or the software interrupt instruction (SWI) When any interrupt occurs the current instruction (including SWI) is completed, processing is suspended, the present CPU state is pushed onto the stack, the interrupt bit (I) in the Condition Code Register is set, the address of the interrupt routine is obtained from the appropriate interrupt vector address, and the interrupt routine is executed Stacking the CPU register, setting the I-bit, and vector fetching require a total of 11 t_{CVC} periods for completion. A flowchart of the interrupt sequence is shown in Figure 15. The interrupt service routine must end with a return from interrupt (RTI) instruction which allows the MCU to resume processing of the program prior to the interrupt (by unstacking the previous CPU state) Table 1 provides a listing of the interrupts, their priority, and the address of the vector which contains the starting address of the appropriate interrupt service routine. The interrupt priority applies to those pending when the CPU is ready to accept a new interrupt (RESET is listed in Table 1 because it is treated as an interrupt. However, it is not normally used as an interrupt.) When the interrupt mask bit in the Condition Code Register is set the interrupt is latched for later interrupt execution

TABLE 1 - INTERRUPT PRIORITIES

| Interrupt | Priority | Vector Address |
|-----------|----------|-----------------|
| RESET | 1 | \$FFE and \$FFF |
| SWI | 2* | \$FFC and \$FFD |
| ĪNT | 3 | \$FFA and \$FFB |
| TIMER | 4 | \$FF8 and \$FF9 |

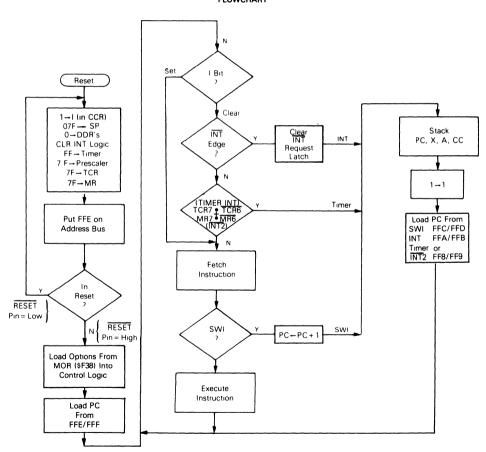
♣ Priority 2 applies only when the I-bit in the Condition Code Register is set (as when a service routine is occurring) When I = 0 and all interrupts are being accepted, SWI has a priority of 4 (like any other instruction) The priority of INT thus becomes 2 and the timer becomes 3

Note

The timer and $\overline{\text{INT2}}$ share the same vector address. The interrupt routine must determine the source by examining the interrupt request bits (TCR b7 and MR b7). Both TCR b7 and MR b7 can only be written to "O" by software

The external interrupt, $\overline{\text{INT}}$ and $\overline{\text{INT2}}$, are synchronized and then latched on the falling edge of the input signal. The $\overline{\text{INT2}}$ interrupt has an interrupt request bit (bit 7) and a mask bit (bit 6) located in the Miscellaneous Register (MR), refer figure 18. The $\overline{\text{INT2}}$ interrupt is inhibited when the mask bit is set. The $\overline{\text{INT2}}$ is always read as a digital input on Port D.

FIGURE 15 — RESET AND INTERRUPT PROCESSING FLOWCHART



The INT2 and timer interrupt request bits, if set, cause the MCU to process an interrupt when the condition code I-bit is clear

A sinusoidal input signl (f_{INT} maximum) can be used to generate an external interrupt, as shown in Figure 16a, for use as a Zero-Crossing Detector. This allows applications such as servicing time-of-day routines and engaging/disengaging AC power control devices. Off-chip full wave rectification provides an interrupt at every zero crossing of the AC signal and thereby provide a 2f clock. For digital application the INT pin can be driven by a digital signal at a maximum period of twu as shown in Figure 16b.

A software interrupt (SWI) is an executable instruction which is executed regardless of the state or the I-bit in the Condition Code Register SWI's are usually used as breakpoints for debugging or as system calls

INPUT/OUTPUT

There are 32 input/output pins. The INT pin may be polled with branch instructions to provide an additional input pin All pins on ports A, B, and C are programmable as either inputs or outputs under software control of the corresponding

Data Direction Register (DDR) The port I/O programming is accomplished by writing the corresponding bit in the port DDR to a logic "1" for output or a logic "0" for input On Reset all the DDRs are initialized to a logic "0" state, placing the ports in the input mode. The port output registers are not initialized on Reset and should be initialized by software before changing the DDRs from input to output. When programmed as outputs, all output ports read latched output data, regardless of the logic levels at the output pin due to output loading, refer to Figure 17.

All input/output lines are TTL compatible as both inputs and outputs Port A lines are CMOS compatible as outputs while port B, C, and D lines are CMOS compatible as inputs Port D lines are input only, thus, there is no corresponding DDR. The second external interrupt input (INT2) is on bit 6 of Port D. When programmed as outputs, port B is capable of sinking 10 milliamperes and sourcing 1.0 milliampere on each pin.

The memory map in Figure 6 gives the addresses of data registers and DDRs. The register configuration is provided in Figure 18. Figure 19 provides some example of port connections.

FIGURE 16 - TYPICAL INTERRUPT CIRCUITS

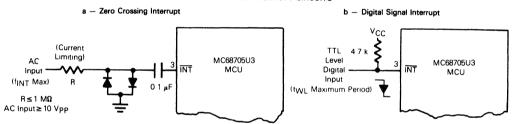
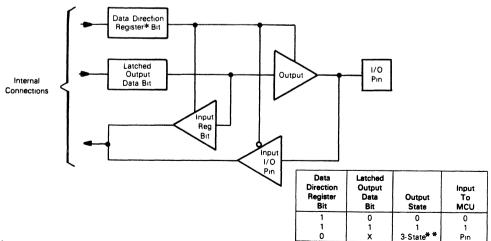


FIGURE 17 - TYPICAL PORT I/O CIRCUITRY



^{*}DDR is a write-only register and reads as all 1's

^{**}Ports B and C are three-state ports. Port A has internal pullup devices to provide CMOS drive capability.

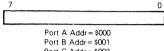
See Electrical Characteristics Table for complete information.

FIGURE 18 - MCU REGISTER CONFIGURATION

PORT DATA DIRECTION REGISTER (DDR) 7 0

- (1) Write Only, reads as all 1s
- (2) 1 = Output, 0 = Input Cleared to 0 by Reset
- (3) Port A Addr = \$004 Port B Addr = \$005 Port C Addr = \$006

PORT DATA REGISTER

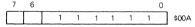


Port C Addr = \$002 Port D Addr = \$003

7 TIMER DATA REGISTER (TDR) 0

MSB LSB \$008

MISCELLANEOUS REGISTER (MR)



Bit 7—INT2 Interrupt Request Bit Set when falling edge detected on INT2 pin, must be cleared by software. Cleared by 0 to Reset _____

Bit 6 – INT2 Interrupt Mask Bit 1 = INT2 Interrupt masked (disabled) Set to 1 by Reset

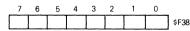
Bits 5, 4, 3, 2, 1, 0 – Read as 1s – unused bits

TIMER CONTROL REGISTER (TCR)

| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | |
|---|---|---|---|---|---|---|---|-------|
| | | | | | | | | \$009 |

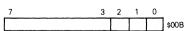
See detail description in TIMER CONTROL REGISTER section

MASK OPTION REGISTER (MOR)



See detail description in MASK OPTIONS section

PROGRAMMING CONTROL REGISTER (PCR)



See detail description in ON-CHIP PROGRAMMING HARDWARE section

Caution

The corresponding DDRs for ports A, B, and C are write-only registers (registers at \$004, \$005, and \$006) A read operation on these registers is undefined Since BSET and BCLR are read/modify/write in function, they cannot be used to set or clear a single DDR bit (all "unaffected" bits would be set). It is recommended that all DDR bits in a port must be written using a single-store instruction.

The latched output data bit (see Figure 17) may always be written. Therefore any write to a port writes all of its data bits even though the port DDR is set to input. This may be used to initialize the data registers and avoid undefined outputs, however, care must be exercised when using read/modify/write instructions since the data read corresponds to the pin level if the DDR is an input (0) and corresponds to the latched output data when the DDR is an output (1)

TIMER CONTROL REGISTER (TCR)

The configuration of the TCR is determined by the logic level of bit 6 (Timer Option, TOPT) in the Mask Option Register (MOR) Two configurations of the TCR are shown below, one for TOPT=1 and the other for TOPT=0 TOPT=1 configures the TCR to emulate the MC6805U2 When TOPT=0, it provides software control of the TCR When TOPT=1, the prescaler "mask" options are user programmable via the MOR A description of each TCR bit is provided below (also see Figure 9 and TIMER section)

| b7 | b6 | b5 | b4 | b3 | b2 | b1 | b0 | |
|-----|-----|----|----|------|----|----|----|---------------------------------|
| TIR | TIM | 1 | 1 | PSC* | 1 | 1 | 1 | Timer Control Register \$009 |

TCR with MOR TOPT = 1 (MC6805R2 Emulation)

| b7 | | | | b3 | | | b0 | |
|-----|-----|-----|-----|------|-----|-----|-----|---------------------------------|
| TIR | TIM | TIN | TIE | PSC* | PS2 | PS1 | PS0 | Timer Control Register \$009 |

TCR with MOR TOPT = 0 (Software Programmable Timer)

* = write only, reads as a zero

b7, TIR Timer Interrupt Request – Used to initiate the timer interrupt or signal a Timer Data Register underflow when it is a logical "1"

1 = Set when the Timer Data Register changes to all zeros

0 = Cleared by external reset or under program control

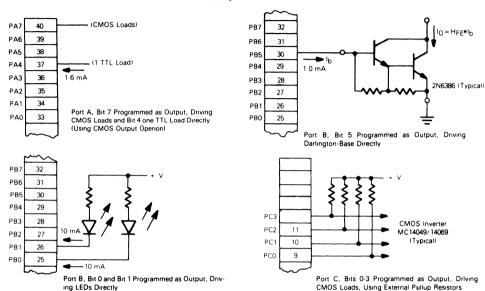
b6, TIM Timer Interrupt Mask—Used to inhibit the timer interrupt, to the processor, when it is a logical "1"

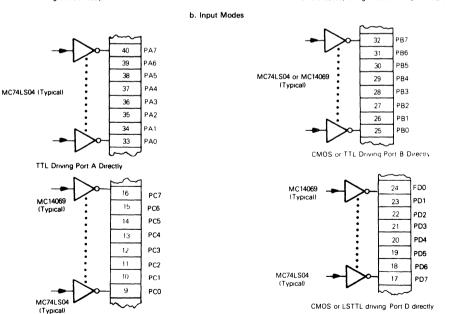
1 = Set by an external reset or under program control

0 = Cleared under program control

FIGURE 19 - TYPICAL PORT CONNECTIONS

a. Output Modes





CMOS and TTL Driving Port C Directly

b5, TIN External or Internal—Selects the input clock source to be either the external TIMER pin (8) or the internal d2

1 = Selects the external clock source 0 = Selects the internal ϕ 2 (fOSC+4)

b4, TIE External Enable — Used to enable the external TIMER pin (8) or to enable the internal clock (if TIN=0) regardless of the external timer pin state (disables gated clock feature) When TOPT=1, TIE is always a logical "1"

1 =Enables external timer pin

0 = Disables external timer pin

TIN-TIE Modes

| TIN | TIE | CLOCK |
|-----|-----|-----------------------------|
| 0 | 0 | Internal Clock (\$\phi\$2) |
| 0 | 1 | Gated (AND) of External and |
| | | Internal Clocks |
| 1 | 0 | No Clock |
| 1 | 1 | External Clock |

b3, PSC Prescaler Clear — This is a write-only bit. It reads as a logical zero so the BSET and BCLR on the TCR function correctly. Writing a "1" into PSC generates a pulse which clears the prescaler b2, PS2 Prescaler Select — These bits are decoded to select one of eight taps on the timer prescaler.

b0, PS0 The table shows the prescaler division resulting from decoding these bits

| PS2 | PS1 | PS0 | Prescaler Division |
|-----|-----|-----|----------------------|
| 0 | 0 | 0 | 1 (Bypass Prescaler) |
| 0 | 0 | 1 | 2 |
| 0 | 1 | 0 | 4 |
| 0 | 1 | 1 | 8 |
| 1 | 0 | 0 | 16 |
| 1 | 0 | 1 | 32 |
| 1 | 1 | 0 | 64 |
| 1 | 1 | 1 | 128 |

Note

When changing the PS2-0 bits in software, the PSC bit should be written to a "1" in the same write cycle to clear the prescaler Changing the PS bits without clearing the prescaler may cause an extraneous toggle of the Timer Data Register

MASK OPTIONS

The MC68705R3 Mask Option Register is implemented in EPROM. Like all other EPROM bytes, the MOR contains all zeros prior to programming.

When used to emulate the MC6805U2, five of the eight MOR bits are used in conjunction with the prescaler. Of the remaining, the b7 bit is used to select the type of clock oscillator and bits b3 and b4 are not used. Bits b0, b1, and b2 determine the division the Timer prescaler. Bit b5 determines the Timer clock source. The value of the TOPT bit (b6) is programmed to configure the TCR (a logic "1" for MC6805R2 emulation).

If the MOR Timer Option (TOPT) bit is a 0, bits b5, b4, b2, b1, and b0 set the initial value of their respective TCP bits

during reset. After initialization the TCR is software controllable.

A description of the MOR bits is as follows

| b7 | b6 | b5 | b4 | b3 | b2 | b1 | ь0 | Mask Option |
|-----|------|-----|----|----|----|----|----|----------------|
| CLK | ТОРТ | CLS | | | P2 | P1 | P0 | Register \$F38 |

b7, CLK Clock Oscillator Type 1 = RC

0 = Crystal

Note

VINTP on the TIMER/BOOT pin (8) forces the crystal mode

b6, TOPT Timer Option

1 = MC6805U2 type timer/prescaler All bits, except 3, 6, and 7, of the Timer Control Register (TCT) are invisible to the user Bits 5, 2, 1, and 0 of the Mask Option Register determine the equivalent MC6805U2 mask options

0= All TCR bits are implemented as a Software Programmable Timer. The state of MOR bits 5, 4, 2, 1, and 0 sets the initial values of their respective TCR bits (TCR is then software controlled after initialization).

b5, CLS Timer/Clock Source
1 = External TIMER pin
0 = Internal d2

b4 Not used if MOR TOPT = 1 (MC6805R2 emulation)
Sets initial value of TCR TIE if MOR TOPT = 0

b3 Not used

b2, P2 Prescaler Option—the logical levels of these b1, P1 bits, when decoded, select one of eight taps on the timer prescaler. The table below shows the division resulting from decoding combinations of these three bits

| | P2 | P1 | P0 | Prescaler Division |
|---|----|----|----|----------------------|
| - | 0 | 0 | 0 | 1 (Bypass Prescaler) |
| 1 | 0 | 0 | 1 | 2 |
| | 0 | 1 | 0 | 4 |
| 1 | 0 | 1 | 1 | 8 |
| ı | 1 | 0 | 0 | 16 |
| ١ | 1 | 0 | 1 | 32 |
| ĺ | 1 | 1 | 0 | 64 |
| 1 | 1 | 1 | 1 | 128 |

Two examples for programming the MOR are discussed below

Example 1 To emulate an MC6805U2 to verify your program with an RC oscillator, and an event count input for the timer with no prescaling, the MOR would be set to "11111000" To write the MOR, it is simply programmed as any other EPROM byte

Example 2 Suppose you wish to use the MC68705U3 programmable prescaler functions, and you wish the initial condition of the prescaler to be divided by 64, with the input disabled and an internal clock source. If the clock oscillator was to be in the crystal mode, the MOR would be set to "00001110".

ON-CHIP PROGRAMMING HARDWARE

The Programming Control Register (PCR) at location \$00B is an 8-bit register which utilizes the three LSBs (the five MSBs are set to logic "1s") This register provides the necessary control bits to allow programming the MC68705U3 EPROM The bootstrap program manipulates the PCR when programming so that users need not be concerned with the PCR in most applications. A description of each bit follows.

| Programming | ь0 | ь1 | b2 | b3 | b4 | b5 | b6 | b7 |
|----------------|-----|-----|------|----|----|----|----|----|
| Control | PLE | PGE | VPON | 1 | 1 | 1 | 1 | 1 |
| Register \$006 | | | | Ц | | | | |

b0, PLE Programming Latch Enable - When cleared this bit allows the address and data to be latched into the EPROM. When this bit is set, data can be read from the EPROM

1 = (set) read EPROM

0 = (clear) latch address and data into EPROM (read disabled)

PLE is set during a Reset, but may be cleared any time. However, its effect on the EPROM is inhibited if VPON is a logic "1"

b1, PGE Program Enable – When cleared, $\overline{\text{PGE}}$ enables programming of the EPROM PGE can only be cleared if PLE is cleared PGE must be set when changing the address and data, i.e., setting up the byte to be programmed

1 = (set) inhibit EPROM programming

0 = (clear) enable EPROM programming (if PLE is low)

PGE is set during a Reset, however, it has not effect on EPROM circuits if VPON is a logic "1"

b2 VPON (Vpp ON) - VPON is a read-only bit and when at a logic "0" it indicates that a "high voltage" is present at the Vpp pin

1 = no "high voltage" on Vpp pin

0 = "high voltage" on Vpp pin VPON being "1" "disconnects" PGE and PLE

from the rest of the chip, preventing accidental clearing of these bits from effecting the normal operating mode

Note

VPON being "0" does not indicate that the Vpp level is correct for programming. It is used as a safety interlock for the user in the normal operating mode

The Programming Control Register functions are shown below

| VPON | PGE | PLE | Programming Conditions |
|------|-----|-----|---|
| 0 | 0 | 0 | Programming mode (program EPROM byte) |
| 1 | 0 | 0 | PGE and PLE disabled from system |
| 0 | 1 | 0 | Programming disabled (latch address and |
| | | | data in EPROM) |
| 1 | 1 | 0 | PGE and PLE disabled from system |
| 0 | 0 | 1 | Invalid state, PGE=0 iff PLE=0 |
| 1 | 0 | 1 | Invalid state, PGE = 0 iff PLE = 0 |
| 0 | 1 | 1 | "High voltage" on Vpp |
| 1 | 1 | 1 | PGE and PLE disabled from system |
| | | | (Operating Mode) |

ERASING THE EPROM

The MC68705U3 EPROM can be erased by exposure to high-intensity ultraviolet (UV) light with a wavelength of 2537 Å The recommended integrated dose (UV intensity x exposure time) is 15 Ws/cm² The lamps should be used without shortwave filters and the MC68705R3 should be positioned about one inch from the UV tubes. Ultraviolet erasure clears all bits of the MC68705U3 EPROM to the "0" state Data is then entered by programming "1s" into the desired bit locations

Caution

Be sure that the EPROM window is shielded from light except when erasing. This protects both the EPROM and light-sensitive nodes

PROGRAMMING FIRMWARE

The MC68705U3 has 191 bytes of mask ROM containing a bootstrap program which can be used to program the MC68705U3 EPROM The vector at addresses \$FF6 and \$FF7 is used to start executing the program. This vector is fetched when VIHTP is applied to pin 8 (TIMER/BOOT pin) of the MC68705U3 and the RESET pin is allowed to rise above VIRES + Figure 20 provides a schematic diagram of a circuit and a summary of programming steps which can be used to program the EPROM in the MC68705U3

PROGRAMMING STEPS

The MCM2532 UV EPROM must first be programmed with an exact duplicate of the information that is to be transferred to the MC68705U3 Non-EPROM addresses are ignored by the bootstrap Since the MC68705U3 and the MCM2532 are to be inserted and removed from the circuit they should be mounted in sockets. In addition, the precaution below must be observed (refer to Figure 20)

Caution

Be sure S1 and S2 are closed and V_{CC} and +26 V are not applied when inserting the MC68705R3 and MCM24332 into their respective sockets. This ensures that RESET is held low while inserting the devices

When ready to program the MC68705U3 it is only necessary to provide VCC and +26 V, open switch S2 (to apply Vpp and VIHTP) and then open S1 (to remove Reset) Once the voltages are applied and both S2 and S1 are open, the CLEAR output control line (PBA) goes high and then low, then the 12-bit counter (MC14040B) is clocked by the PB3 output (COUNT) The counter selects the MCM2532 EPROM byte which is to load the equivalent MC68705U3 EPROM byte selected by the bootstrap program. Once the EPROM location is loaded, COUNT clocks the counter to the next EPROM location. This continues until the MC68705U3 is completely programmed at which time the Programmed indicator LED is lit. The counter is cleared and the loop is repeated to verify the programmed data. The Verified indicator LED lights if the programming is correct

Once the MC68705U3 has been programmed and verified, close switch S2 (to remove Vpp and VIHTP) and close switch S1 (to Reset) Disconnect +26 V and VCC, then remove the MC68705U3 from its socket

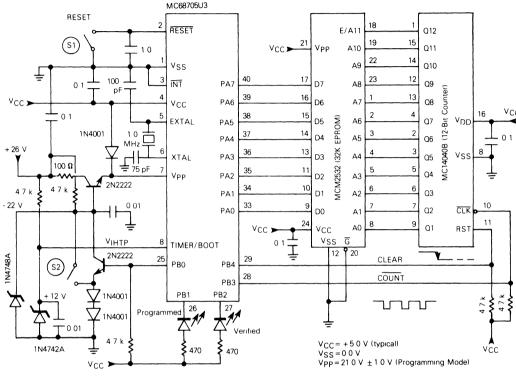


FIGURE 20 - PROGRAMMING CONNECTIONS SCHEMATIC DIAGRAM

Summary of Programming Steps

- 1 When plugging in the MC68705R3 or the MCM2532 be sure that S1 and S2 are closed and that V_{CC} and +26 V are not applied
- 2 To initiate programming, be sure S1 is closed, S2 is closed and V_{CC} and +26 V are applied. Then open S2, followed by S1
- 3 Before removing the MC68705R3, first close S2 and then close S1 Disconnect VCC and +26 V then remove the MC68705R3

MC6805U2 EMULATION

The MC68705U3 emulates the MC6805U2 "exactly" MC6805U2 mask features are implemented in the Mask Option Register (MOR) EPROM byte on the MC68705U3 There are a few minor exceptions to the exactness of emulation which are listed below

- 1 The MC6805U2 "future ROM" area is implemented in the MC68705U3 and these 1728 bytes must be left unprogrammed to accurately simulate the MC6805U2 (The MC6805U2 reads all zeros from this area)
- 2 The reserved ROM areas in the MC6805U2 and MC68705U3 have different data stored in them and this data is subject to change without notice. The MC6805U2 uses the reserved ROM for the Self-Check feature and the MC68705U3 uses this area for the bootstrap program.
- 3 The MC6805U2 reads all ones in its 48 byte "future RAM" area This RAM is not implemented in the MC6805U2 mask ROM version, but is implemented in the MC68705U3

- 4 The Vpp line (pin 7) in the MC68705U3 must be tied to VCC for normal operation. In the MC6805U2, pin 7 is the NUM pin and is grounded in normal operation.
- 5 The LVI feature is not available in the MC68705U3 Processing differences are not presently compatible with proper design of this feature in the EPROM version
- 6 The function in the Non-User Mode is not identical to the MC6805U2 version Therefore, the MC68705U3 does not function in the MEX6805 Support System In normal operation, all pin functions are the same as on the MC6805U2 version, except for pin 7 as previously noted

The operation of all other circuitry has been exactly duplicated or designed to function exactly the same way in both devices including Interrupts, Timer, Data Ports, and Data Direction Registers (DDRs). A stated design goal has been to provide the user with a safe inexpensive way to verify his program and system design before committing to a factory programmed ROM.

SOFTWARE

BIT MANIPULATION

The MC68705U3 MCU has the ability to set or clear any single random-access memory or input/output bit (except the Data Direction Register, see Caution under INPUT/OUT-PUT paragraph), with a single instruction (BSET, BCLR) Any bit in the page zero memory can be tested, using the BRSET and BRCLR instructions, and the program branches as a result of its state. The Carry bit equals the value of the bit referenced by BRSET and BRCLR A Rotate instruction may then be used to accumulate serial input data in a RAM location or register. This capability to work with any bit in RAM, ROM, or I/O allows the user to have individual flags in RAM or to handle I/O bits as control lines The coding example in Figure 21 illustrates the usefulness of the bit manipulation and test instructions. Assume that the MCU is to communicate with an external serial device. The external device has a data ready signal, a data output line, and a clock line to clock data one bit at a time, LSB first, out of the device. The MCU waits until the data is ready, clocks the external device, picks up the data in the Carry flage (C-bit), clears the clock line, and finally accumulates the data bit in a RAM location

ADDRESSING MODES

The MCU has 10 addressing modes which are explained briefly in the following paragraphs. For additional details and graphical illustration, refer to the M6805 Family Users Manual

The term "effective address" (EA) is used in describing the addressing modes EA is defined as the address from which the argument for an instruction is fetched or stored

IMMEDIATE — In the immediate addressing mode, the operand is contained in the byte immediately following the opcode. The immediate addressing mode is used to access constants which do not change during program execution (e.g., a constant used to initialize a loop counter).

DIRECT — In the direct addressing mode, the effective address of the argument is contained in a single byte following the opcode byte Direct addressing allows the user to directly address the lowest 256 bytes in memory with a single 2-byte instruction. This address area includes all on-chip RAM, I/O registers, and 128 bytes of EPROM. Direct addressing is an effective use of both memory and time.

EXTENDED — In the extended addressing mode, the effective address of the argument is contained in the two bytes following the opcode Instructions using extended addressing are capable of referencing arguments anywhere in memory with a single 3-byte instruction. When using the Motorola assembler, the programmer need not specify whether an instruction uses direct or extended addressing. The assembler automatically selects the shortest form of the instruction.

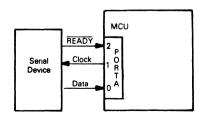
RELATIVE — The relative addressing mode is only used in branch instructions. In relative addressing, the contents of the 8-bit signed byte following the opcode (the offset) is added to the PC, if and only if, the branch condition is true. Otherwise, control proceeds to the next instruction. The span of relative addressing is from —126 to +129 from the opcode address. The programmer need not worry about calculting the correct offset when using the Motorola assembler, since it calculates the proper offset and checks to see if it is within the span of the branch.

INDEXED, NO OFFSET — In the indexed, no offset addressing mode, the effective address of the argument is contained in the 8-bit index register. Thus, this addressing mode can access the first 256 memory locations. These instructions are only one byte long. This mode is often used to move a pointer through a table or to hold the address of a frequency referenced RAM or I/O location.

INDEXED, 8-BIT OFFSET — In the indexed, 8-bit offset addressing mode, the effective address is the sum of the contents of the unsigned 8-bit index register and unsigned byte following the opcode. This addressing mode is useful in selecting the kth element in an n element table. With this 2-byte instruction, k would typically be in X with the address of the beginning of the table in the instruction. As such tables may begin anywhere within the first 256 addressable locations and could extend as far as location 511 (\$1FE).

INDEXED, 16-BIT OFFSET — In the indexed, 16-bit offset addressing mode, the effective address is the sum of the contents of the unsigned 8-bit index register and the two unsigned bytes following the opcode This address mode can be used in a manner similar to indexed, 8-bit offset, except that this 3-byte instruction allows tables to be anywhere in

FIGURE 21 - BIT MANIPULATION EXAMPLE



memory. As with Direct and Extended addressing, the Motorola assembler determines the shortest form of indexed addressing.

BIT SET/CLEAR — In the bit set/clear addressing mode, the bit to be set or cleared is part of the opcode and the byte following the opcode specifies the direct address of the byte in which the specified bit is to be set or cleared Thus, any read/write bit in the first 256 locations of memory, including I/O, can be selectively set or cleared with a single 2-byte instruction. See Caution under the INPUT/OUTPUT paragraph

BIT TEST AND BRANCH — The bit test and branch addressing mode is a combination of direct addressing and relative addressing. The bit which is to be tested and the condition (set or clear) is included in the opcode, and the address of the byte to be tested is in the single byte immediately following the opcode byte. The signed relative 8-bit offset is in the third byte and is added to the value of the PC, if the branch condition is true. This single 3-byte instruction allows the program to branch based on the condition of any readable bit in the first 256 locations of memory. The span of branching is from —125 to +130 from the opcode address. The state of the tested bit is also transferred to the Carry bit of the Condition Code Register. See Caution under the INPUT/OUTPUT paragraph.

INHERENT — In the inherent addressing mode, all the information necessary to execute the instruction is contained in the opcode. Operations specifying only the index register or accumulator, as well as control instruction with no other arguments, are included in this mode. These instructions are one byte long.

INSTRUCTION SET

The MCU has a set of 59 basic instructions, which when combined with the 10 addressing modes produce 207 usable opcodes. They can be divided into five different types.

register/memory, read/modify/write, branch, bit manipulation, and control. The following paragraphs briefly explain each type. All the instructions within a given type are presented in individual tables.

REGISTERS/MEMORY INSTRUCTIONS — Most of these instructions use two operands. One operand is either the accumulator or the index register. The other operand is obtained from memory using one of the addressing modes. The jump unconditional (JMP) and jump to subroutine (JSR) instructions have no register operand. Refer to Table 2.

READ/MODIFY/WRITE INSTRUCTIONS — These instructions read a memory location or a register, modify or test its contents, and write the modified value back to memory or to the register (see Caution under INPUT/OUT-PUT paragraph) The test for negative or zero (TST) instruction is included in the read/modify/write instructions, though it does not perform the write Refer to Table 3

BRANCH INSTRUCTIONS — The branch instructions cause a branch from the program when a certain condition is met. Refer to Table 4

BIT MANIPULATION INSTRUCTIONS — These instructions are used on any bit in the first 256 bytes of the memory (see Caution under INPUT/OUTPUT paragraph). One group either sets or clears. The other group performs the bit test and branch operations. Refer to Table 5.

CONTROL INSTRUCTIONS — The control instructions control the MCU operations during program execution Refer to Table 6

 $\begin{tabular}{ll} ALPHABETICAL LISTING - The complete instruction set is given in alphabetical order in Table 7 \end{tabular}$

 $\mbox{OPCODE MAP SUMMARY}-\mbox{Table 8}$ is an opcode map for the instructions used on the MCU

TABLE 2 - REGISTER/MEMORY INSTRUCTIONS

| | | | | | | | | | A | ddressin | g Mode | es | | | | | | | |
|---|----------|------------|------------|-------------|------------|------------|--------|------------|------------|-------------|------------|----------------|-------------|------------|------------|-------------|------------|------------------|-------------|
| | | | Immed | liate | | Direc | ct | | Extend | ed | | Index No Of | | (8 | Index | | (1 | Index 6-Bit C | |
| Function | Mnemonic | Op Code | # Bytes | # Cycles | Op Code | # Bytes | Cycles | Op Code | # Bytes | # Cycles | Op Code | # Bytes | # Cycles | Op Code | # Bytes | # Cycles | OP Code | # Bytes | # Cycles |
| Load A from Memory | LDA | A6 | 2 | 2 | B6 | 2 | 4 | C6 | 3 | 5 | F6 | 1 | 4 | E6 | 2 | 5 | D6 | 3 | 6 |
| Load X from Memory | LDX | AE | 2 | 2 | BE | 2 | 4 | CE | 3 | 5 | FE | 1 | 4 | EE | 2 | 5 | DE | 3 | 6 |
| Store A in Memory | STA | _ | - | - | B7 | 2 | 5 | C7 | 3 | 6 | F7 | 1 | 5 | E7 | 2 | 6 | D7 | 3 | 7 |
| Store X in Memory | STX | - | - | - | BF | 2 | 5 | CF | 3 | 6 | FF | 1 | 5 | EF | 2 | 6 | DF | 3 | 7 |
| Add Memory to A | ADD | AB | 2 | 2 | BB | 2 | 4 | СВ | 3 | 5 | FB | 1 | 4 | EB | 2 | 5 | DB | 3 | 6 |
| Add Memory and Carry to A | ADC | A9 | 2 | 2 | 89 | 2 | 4 | С9 | 3 | 5 | F9 | 1 | 4 | E9 | 2 | 5 | D9 | 3 | 6 |
| Subtract Memory | SUB | AO | 2 | 2 | BO | 2 | 4 | CO | 3 | 5 | FO | 1 | 4 | EO | 2 | 5 | DO | 3 | 6 |
| Subtract Memory from A with Borrow | SBC | A2 | 2 | 2 | B2 | 2 | 4 | C2 | 3 | 5 | F2 | , | 4 | E2 | 2 | 5 | D2 | 3 | 6 |
| AND Memory to A | AND | A4 | 2 | 2 | B4 | 2 | 4 | C4 | 3 | 5 | F4 | 1 | 4 | E4 | 2 | 5 | D4 | 3 | 6 |
| OR Memory with A | ORA | AA | 2 | 2 | BA | 2 | 4 | CA | 3 | 5 | FA | 1 | 4 | EA | 2 | 5 | DA | 3 | 6 |
| Exclusive OR Memory with A | EOR | AB | 2 | 2 | 88 | 2 | 4 | · CB | ´3 | 5 | F8 | , | 4 | E8 | 2 | 5 | D8 | 3 | 6 |
| Arithmetic Compare A with Memory | СМР | A1 | 2 | 2 | B1 | 2 | 4 | C1 | 3 | 5 | F1 | , | 4 | E1 | 2 | 5 | D1 | 3 | 6 |
| Arithmetic Compare X with Memory | СРХ | А3 | 2 | 2 | 83 | 2 | 4 | сз | 3 | 5 | F3 | 1 | 4 | E3 | 2 | 5 | D3 | 3 | 6 |
| Bit Test Memory with A (Logical Compare) | BIT | A 5 | 2 | 2 | 85 | 2 | 4 | C5 | 3 | 5 | F5 | , | 4 | E5 | 2 | 5 | D5 | 3 | 6 |
| Jump Unconditional | JMP | - | - | - | BC | 2 | 3 | cc | 3 | 4 | FC | 1 | 3 | EC | 2 | 4 | DC | 3 | 5 |
| Jump to Subroutine | JSR | _ | - | - | BD | 2 | 7 | CD | 3 | 8 | FD | 1 | 7 | ED | 2 | 8 | DD | 3 | 9 |

TABLE 3 - READ/MODIFY/WRITE INSTRUCTION

| | | | Addressing Modes | | | | | | | | | | | | | |
|------------------------------|----------|--------------|------------------|-------------|--------------|------------|-------------|------------|------------|--------|------------------------|------------|-------------|---------------------------|------------|-------------|
| | | Inherent (A) | | | Inherent (X) | | | Direct | | | Indexed (No Offset) | | | Indexed (8 Bit Offset) | | |
| Function | Mnemonic | Op Code | # Bytes | # Cycles | Op Code | # Bytes | # Cycles | Op Code | # Bytes | Cycles | Op Code | # Bytes | # Cycles | Op Code | # Bytes | # Cycles |
| Increment | INC | 4C | 1 | 4 | 5C | 1 | 4 | 3C | 2 | 6 | 7C | 1 | 6 | 6C | 2 | 7 |
| Decrement | DEC | 4A | 1 | 4 | 5A | 1 | 4 | 3A | 2 | 6 | 7A | 1 | 6 | 6A | 2 | 7 |
| Clear | CLR | 4F | 1 | 4 | 5F | 1 | 4 | 3F | 2 | 6 | 7F | 1 | 6 | 6F | 2 | 7 |
| Complement | сом | 43 | 1 | 4 | 53 | 1 | 4 | 33 | 2 | 6 | 73 | 1 | 6 | 63 | 2 | 7 |
| Negate (2 s Complement) | NEG | 40 | 1 | 4 | 50 | 1 | 4 | 30 | 2 | 6 | 70 | 1 | 6 | 60 | 2 | 7 |
| Rotate Left Thru Carry | ROL | 49 | 1 | 4 | 59 | 1 | 4 | 39 | 2 | 6 | 79 | 1 | 6 | 69 | 2 | 7 |
| Rotate Right Thru Carry | ROR | 46 | 1 | 4 | 56 | 1 | 4 | 36 | 2 | 6 | 76 | 1 | 6 | 66 | 2 | 7 |
| Logical Shift Left | LSL | 48 | 1 | 4 | 58 | 1 | 4 | 38 | 2 | 6 | 78 | 1 | 6 | 68 | 2 | 7 |
| Logical Shift Right | LSR | 44 | 1 | 4 | 54 | 1 | 4 | 34 | 2 | 6 | 74 | 1 | 6 | 64 | 2 | 7 |
| Arithmetic Shift Right | ASR | 47 | 1 | 4 | 57 | 1 | 4 | 37 | 2 | 6 | 77 | 1 | 6 | 67 | 2 | 7 |
| Test for Negative or Zero | TST | 4D | 1 | 4 | 5D | 1 | 4 | 3D | 2 | 6 | 7D | 1 | 6 | 6D | 2 | 7 |

TABLE 4 - BRANCH INSTRUCTIONS

| | | Rela | tive Addres | sing Mode |
|--|----------|------------|-------------|-------------|
| Function | Mnemonic | Op Code | Bytes | g Cycles |
| Branch Always | BRA | 20 | 2 | 4 |
| Branch Never | BRN | 21 | 2 | 4 |
| Branch IFF Higher | BHI | 22 | 2 | 4 |
| Branch IFF Lower or Same | BLS | 23 | 2 | 4 |
| Branch IFF Carry Clear | BCC | 24 | 2 | 4 |
| (Branch IFF Higher or Same) | (BHS) | 24 | 2 | 4 |
| Branch IFF Carry Set | BCS | 25 | 2 | 4 |
| (Branch IFF Lower) | (BLO) | 25 | 2 | 4 |
| Branch IFF Not Equal | BNE | 26 | 2 | 4 |
| Branch IFF Equal | BEQ | 27 | 2 | 4 |
| Branch IFF Half Carry Clear | внсс | 28 | 2 | 4 |
| Branch IFF Half Carry Set | BHCS | 29 | 2 | 4 |
| Branch IFF Plus | BPL | 2A | 2 | 4 |
| Branch IFF Minus | BMI | 2B | 2 | 4 |
| Branch IFF Interrupt Mask Bit is Clear | BMC | 2C | 2 | 4 |
| Branch IFF Interrupt Mask Bit is Set | BMS | 2D | 2 | 4 |
| Branch IFF Interrupt Line is Low | BIL | 2E | 2 | 4 |
| Branch IFF Interrupt Line is High | BIH | 2F | 2 | 4 |
| Branch to Subroutine | BSR | AD | 2 | 8 |

TABLE 5 - BIT MANIPULATION INSTRUCTIONS

| | | | Addressing Modes | | | | | | | | | | | |
|---------------------------|-------------------|------------|------------------|--------|------------|---------------------|-------------|--|--|--|--|--|--|--|
| | | E | Int Set/Clea | Г | В | Bit Test and Branch | | | | | | | | |
| Function | Mnemonic | Op Code | # Bytes | Cycles | Op Code | # Bytes | f Cycles | | | | | | | |
| Branch IFF Bit n is set | BRSET n (n = 0 7) | _ | - 1 | | 2 • n | 3 | 10 | | | | | | | |
| Branch IFF Bit n is clear | BRCLR n (n = 0 7) | _ | - 1 | _ | 01 + 2 • n | 3 | 10 | | | | | | | |
| Set Bit n | BSET n (n = 0 7) | 10 + 2 • n | 2 | 7 | 1 - 1 | _ | _ | | | | | | | |
| Clear Bit n | BCLR n (n = 0 7) | 11 + 2 • n | 2 | 7 | T - T | _ | - | | | | | | | |

TABLE 6 - CONTROL INSTRUCTIONS

| | | | Inherer | nt |
|--------------------------|----------|------------|------------|-------------|
| Function | Mnemonic | Op Code | # Bytes | # Cycles |
| Transfer A to X | TAX | 97 | 1 | 2 |
| Transfer X to A | TXA | 9F | 1 | 2 |
| Set Carry Bit | SEC | 99 | 1 | 2 |
| Clear Carry Bit | CLC | 98 | 1 | 2 |
| Set Interrupt Mask Bit | SEI | 98 | 1 | 2 |
| Clear Interrupt Mask Bit | CLI | 9A | 1 | 2 |
| Software Interrupt | SWI | 83 | 1 | 11 |
| Return from Subroutine | RTS | 81 | 1 | 6 |
| Return from Interrupt | RTI | 80 | 1 | 9 |
| Reset Stack Pointer | RSP | 9C | 1 | 2 |
| No-Operation | NOP | 9D | 1 | 2 |

TABLE 7 - INSTRUCTION SET

| | | | | | Addressin | g Modes | | | | | Condition | | | Co | des |
|----------|----------|-----------|--------|--------------|-----------|------------------------|---------------------|----------------------|----------------------|-------------------------|-----------|---|---|----|-----|
| Mnemonic | Inherent | Immediate | Direct | Extended | Relative | Indexed (No Offset) | Indexed (8 Bits) | Indexed (16 Bits) | Bit Set/ Clear | Bit Test & Branch | н | 1 | N | z | С |
| ADC | 1 | × | × | X | | X | × | × | | <u> </u> | Λ | • | Λ | Λ | Λ |
| ADD | | X | × | × | | × | X | x | | | Λ | • | Λ | Λ | Λ |
| AND | † | X | × | × | | X | X | × | | | • | • | Λ | Λ | • |
| ASL | × | | X | | | × | × | | | | • | • | Λ | Λ | Λ |
| ASR | × | | × | <u> </u> | | X | × | | | | • | • | Λ | Λ | Λ |
| BCC | | | | <u> </u> | X | · | | | | | • | • | • | • | • |
| BCLR | | | | 1 | | | | | X | | • | • | • | • | • |
| BCS | | | | † | X | | | | | | • | • | • | • | • |
| BEQ | | | | | X | | | | | | • | • | • | • | • |
| ВНСС | 1 | | | | Х | <u> </u> | | | | | • | • | • | • | • |
| BHCS | | | | 1 | X | | | | | | • | • | • | • | • |
| BHI | | | | | X | | | | | | • | • | • | • | • |
| BHS | | | | 1 | Х | | | | | | • | • | • | • | • |
| BIH | | | | | X | | | | | | • | • | • | • | • |
| BIL | | | | † | X | | | | | | • | • | • | • | • |
| BIT | | Х | X | X | | Х | Х | X | | | • | • | Λ | Λ | • |
| BLO | | | | | X | | | | | | • | • | • | • | • |
| BLS | | | | | X | | | | | | • | • | • | • | • |
| вмс | † | | | | Х | | | | | | • | • | • | • | • |
| ВМІ | | | | | X | | | | | | • | • | • | • | • |
| BMS | | | | | X | | | | | | • | • | • | • | • |
| BNE | | | | | X | | | | | | • | • | • | • | • |
| BPL | | | | | Х | | | | | | • | • | • | • | • |
| BRA | 1 | | | 1 | X | | | | | | • | • | • | • | • |
| BRN | | | | | Х | | | | | | • | • | • | • | • |
| BRCLR | | | | | | | | | | X | • | • | • | • | Λ |
| BRSET | | | | | | | | | | × | • | • | • | • | Λ |
| BSET | | | | | | | | | X | | • | • | • | • | • |
| BSR | | | | | X | | | | | | • | • | • | • | • |
| CLC | X | | | | | | | | | | • | • | • | • | 0 |
| CLI | X | | | | | | | | | | • | 0 | • | • | • |
| CLR | Х | | X | | | X | × | | | | • | • | 0 | 1 | • |
| CMP | | Х | × | × | | X | × | × | | | • | • | Λ | Λ | Λ |
| COM | Х | | X | | | X | X | | | | • | • | Λ | Λ | 1 |
| CPX | | Х | X | X | | X | X | X | | l | • | • | Λ | Λ | Λ |

Condition Code Symbols

- Half Carry (From Bit 3) н
- Interrupt Mask
- Negative (Sign Bit)
- N Z C A Zero
- Carry/Borrow
- Test and Set if True, Cleared Otherwise
- Not Affected
- Load CC Register From Stack
- Set Clear

TABLE 7 - INSTRUCTION SET (CONTINUED)

| | T | | | | Addressin | Modes | | | | | Coi | ndi | tion | Co | des |
|----------|----------|-----------|--------|----------|-----------|------------------------|---------------------|----------------------|----------------------|-------------------------|-----|-----|------|----|-----|
| Mnemonic | Inherent | Immediate | Direct | Extended | Relative | Indexed (No Offset) | Indexed (8 Bits) | Indexed (16 Bits) | Bit Set/ Clear | Bit Test & Branch | н | | N | z | С |
| DEC | X | | Х | | | X | Х | | | | • | • | Λ | Λ | • |
| EOR | | X | X | X | | X | Х | X | | | • | • | Λ | Λ | • |
| INC | X | | X | | | X | х | | | | • | • | Λ | Λ | • |
| JMP | 1 | | Х | X | | X | × | X | | | • | • | • | • | • |
| JSR | | | × | X | | × | X | X | | | • | • | • | • | • |
| LDA | | X | Х | X | | × | X | X | | | • | • | Λ | Λ | • |
| LDX | 1 | Х | X | X | | × | X | X | | | • | • | Λ | Λ | • |
| LSL | × | | X | | | X | X | | | | • | • | Λ | Λ | Λ |
| LSR | X | | Х | | | × | X | | | | • | • | 0 | Λ | Λ |
| NEQ | X | | Х | | | X | × | 1 | | | • | • | Λ | Λ | Λ |
| NOP | X | | | 1 | | | | | | | • | • | • | • | • |
| ORA | 1 | X | X | × | | X | × | × | | | • | • | Λ | Λ | • |
| ROL | X | | Х | | | X | X | | | | • | • | Λ | Λ | Λ |
| RSP | X | | | | | 1 | | | | | • | • | • | • | • |
| RTI | X | | | | | | | | | | 7 | 7 | 7 | 7 | 7 |
| RTS | X | | | | | | | | | | • | • | • | • | • |
| SBC | 1 | X | Х | X | | X | × | × | | | • | • | Λ | Λ | Λ |
| SEC | X | | | | | | | | | | • | • | • | • | 1 |
| SEI | X | | | | | | | | | | • | 1 | • | • | • |
| STA | 1 | | Х | X | | Х | X | × | | | • | • | Λ | Λ | • |
| STX | | | × | X | | X | × | × | | 1 | • | • | Λ | Λ | • |
| SUB | 1 | X | X | X | | Х | × | X | | | • | • | Λ | Λ | Λ |
| SWI | X | | | 1 | | | | | | 1 | • | 1 | • | • | • |
| TAX | X | | | T | 1 | | | 1 | | 1 | • | • | • | • | • |
| TST | X | | Х | I | | Х | х | | | | • | • | Λ | Λ | • |
| TXA | X | | | 1 | | | | 1 | | | • | • | • | • | • |

Condition Code Symbols

- Half Carry (From Bit 3)
- 1 Interrupt Mask
- Ν Negative (Sign Bit)
- Zero
- z C Carry/Borrow
- ٨ Test and Set if True, Cleared Otherwise
- Not Affected
- ? Load CC Register From Stack
- Set Clear

TABLE 8 - M6805 FAMILY INSTRUCTION SET OPCODE MAP

| | Bit Ma | nipulation | Branch | | Re | ed/Modify/ | Write | | Con | rtroi | | | Registe | r/Memory | | | |
|-----------|--|---------------------|---------------------|---------------------|----------------------|----------------------|----------------|----------|-----------------------|----------------|-------------------|----------------|---------------------|------------------|------------------|--------------------|------------------|
| L | BTB | BSC | REL | DIR | INH(A) | INH(X) | IX1 | IX. | INH | INH | IMM | DIR | EXT | IX2 | IX1 | IX | iI |
| Low | - eee | 0001 | 0010 | 0011 | 0100 | 0101 | 0110 | 0111 | 1000 | 1001 | 1010 | 1011 | 1100 | 1101 | 1110 | 1111 | HI LOW |
| 0000 | BRSETO 3 BTB | 7 BSET0 2 BSC | BRA REL | 6 NEG 2 DIR | NEGA 1 INH | 4 NEGX 1 INH | / NEG 6 | 6 NEG 5 | RTI 1 INH | | SUB 2 | SUB DIR | SUB 3 EXT | SUB 3 IX2 | SUB IX1 | SUB | 0000 0000 |
| 0001 | BRCLRO BRBBBBBBBBBBBBBBBBBBBBBBBBBBBBBBBBBB | BCLR0 5 | BRN 3 | | ! | | | | 6 RTS | | CMP 2 | 4 CMP 2 DIR | 5 CMP 3 EXT | 6 CMP 5 | 5 CMP 1X1 | CMP 3 | 1 0001 |
| 0010 | BRSET1 3 BTB | BSET1 2 BSC | 4 BHI 2 REL | | | | | | | | SBC 2 | SBC 3 | SBC 3 EXT | SBC S | SBC 4 | SBC IX | 2 0010 |
| 3 0011 | BRCLR1 BRBB | BCLR1 BSC | BLS 2 REL | 6 COM 2 DIR | COMA 1 INH | COMX NH | COM 2 IX1 | 6 COM | 11 10 SWI 1 INH | | CPX 2 | 4 CPX 2 DIR | 5 CPX 3 EXT | CPX 3 IX2 | CPX 2 IX1 | CPX | 3 0011 |
| 4 0100 | BRSET2 3 BTB | 7 BSET2 2 BSC | BCC REL | 6 LSR 2 DIR | LSRA | 4 LSRX 1 INH | 7 LSR 2 IX1 | 6 LSR 1 | | | AND 2 | 4 AND 2 DIR | 5 AND 3 EXT | AND 3 IX2 | 5 AND 2 IX1 | 4 AND 1X | 4 0100 |
| 5 0101 | BRCLR2 - 3 BTB | BCLR2 5 | BCS REL | | | | | | | | BIT 2 | BIT DIR | BIT 3 EXT | 6 BIT 3 IX2 | 5 BIT 2 IX1 | 4 3 BIT 1 IX | 5 0101 |
| 6 0110 | BRSET3 | BSET3 5 | 4 BNE 3 | 6 FOR 2 DIR | RORA 1 INH | RORX 1 INH | ROR 2 IX1 | 6 ROR 5 | | | LDA 2 | 4 LDA 2 DIR | 5 4 LDA 3 EXT | 6 LDA 3 IX2 | 5 LDA 4 2 IX1 | LDA 3 | 6 0110 |
| 7 0111 | BRCLR3 3 BTB | BCLR3 5 | BEQ 3 | 6 ASR 5 | ASRA 1 INH | 4 ASRX 1 INH | 7 ASR 2 IX1 | 6 ASR 5 | | TAX | | 5 STA 2 DIR | 6 STA 3 EXT | 7 STA 6 3 IX2 | 6 STA 5 | STA | 7 0111 |
| 8 1000 | BRSET4 | BSET4 5 | BHCC REL | 6 LSL 2 DIR | 4 LSLA 1 JNH | 4 3 LSLX 1 INH | 7 LSL 2 IX1 | 6 LSL 5 | | CLC INH | EOR 1MM | EOR DIR | 5 EOR 3 EXT | 6 EOR 5 3 IX2 | 5 EOR 2 IX1 | EOR X | 8 1000 |
| 9 | BRCLR4 3 BTB | BCLR4 5 | BHCS REL | 6 ROL 2 DIR | ROLA 1 INH | ROLX 1 INH | 7 ROL 2 IX1 | 6 ROL 1 | | SEC 1 INH | ADC 2 | ADC DIR | 5 ADC 3 EXT | ADC IX2 | 5 ADC 2 | ADC 1 | 9 1001 |
| A 1010 | BRSET5 3 BTB | 7 BSET5 2 BSC | 4 BPL 2 REL | 6 DEC 5 | DECA 1 INH | 4 DECX 1 INH | 7 DEC 2 IX1 | 6 DEC 1X | | CLI INH | ORA 2 IMM | ORA DIR | ORA 3 EXT | ORA 3 IX2 | 5 ORA 2 IX1 | ORA 1 | A 1010 |
| B 1011 | BRCLR5 3 BTB | BCLR5 2 BSC | 4 BMI 2 REL | | | | | - | | SEI | ADD 2 IMM | 4 ADD DIR | ADD 3 EXT | 6 ADD 3 | 5 ADD 2 IX1 | ADD 1X | B 1011 |
| C 1100 | BRSET6 | BSET6 5 | BMC REL | 6 5 INC 2 DIR | INCA 1 INH | 4 3 INCX 1 INH | INC 1X1 | 6 INC 1 | | 2 RSP 1 INH | | JMP 2 DIR | JMP 3 EXT | 5 JMP 3 IX2 | 4 JMP 2 IX1 | JMP 1 IX | C 1100 |
| D 1101 | BRCLR6 3 BTB | BCLR6 S | BMS REL | 6 TST 2 DIR | TSTA 1 INH | TSTX 1 INH | 7 TST 2 IX1 | 6 TST | | 2 NOP 1 INH | BSR BSR REL | JSR 2 DIR | B 6 JSR 3 EXT | JSR 3 IX2 | 8 JSR 2 IX1 | 7 JSR 1 1X | D 1101 |
| E 1110 | 10 5 BRSET7 3 818 | BSET7 5 | 4 3 BIL 2 REL | | | | | | STOP 2 | | 2 LDX 2 IMM | LDX 2 DIR | 5 LDX 3 EXT | LDX 3 IX2 | 5 LDX 2 IX1 | LDX 1 | E 1110 |
| F 1111 | BRCLR7 B BTB | 7 BCLR7 2 BSC | 4 3 BIH 2 REL | 6 5 CLR 2 DIR | 4 3 CLRA 1 INH | 4 3 CLRX 1 INH | 7 CLR 2 IX1 | 6 CLR 1X | WAIT 1 INH | 2 TXA 1 INH | | STX 2 DIR | STX SEXT | 7 STX 3 IX2 | 6 STX 2 IX1 | STX | F 1111 |

Abbreviations for Address Modes

 INH
 Inherent

 IMM
 Immediate

 DIR
 Direct

 EXT
 Extended

 REL
 Relative

 BSC
 Bit Set/Clear

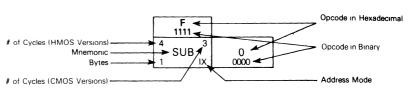
 BTB
 Bit Test and Branch

IX Indexed (No Offset)
IX1 Indexed, 1 Byte (8-Bit) Offset

IX2 Indexed, 2 Byte (16-Bit) Offset

* CMOS Versions Only

LEGEND





MC141000 MC141200 MC141099

Advance Information

4-BIT SINGLE-CHIP CMOS MICROCOMPUTERS

The MC141000 and MC141200 are 4-bit, CMOS single-chip microcomputers. These static microcomputers contain CPU, ROM, RAM, PLA, buffered inputs, and output drivers capable of sourcing more than 12 milliamperes. The MC141200 has 16 individually alterable outputs (R-lines) in a 40-pin package. The MC141000 is a limited pinout version of the MC141200 with 11 R-lines in a 28-pin package. The output drivers for the MC141000 and MC141200 are mask programmed to be either open-emitter, open-drain, or active push-pull. Both versions include 8 0-outputs from a mask programmable PLA.

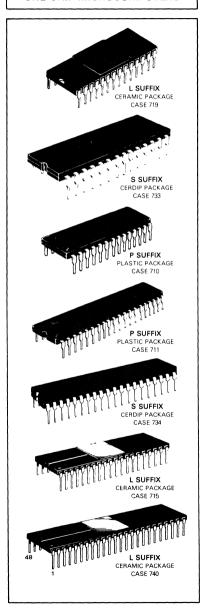
The MC141099 is a 48-pin version of the MC141200 designed for use as a prototyping and debugging tool. The MC141099 contains no ROM or PLA on-board, however, address and data lines required to interface to external ROM and PLA are provided. All MC141099 outputs are active push-pull.

| Features | 3 | MC141000 | MC141200 | MC141099 | | | | |
|------------------------|--------------|----------|---------------|----------|--|--|--|--|
| Package Pin Count | | 28 Pins | 40 Pins | 48 Pins | | | | |
| Instruction Read-Only | Memory | 999×8 (7 | 7992 Bits) | None | | | | |
| Data Random-Access | Memory | 6 | 4×4 (256 Bits | 3) | | | | |
| "R" Individually Addre | ssed Outputs | 11 | 16 | 16 | | | | |
| "O" Parallel Latched D | Data Outputs | 8 8 | Bits | 5 Bits | | | | |
| "R" and "O" Output [| Drive | | Source 12 mA | 4 | | | | |
| Maximum-Rated Volta | ge | | 65 V | | | | | |
| "K" Inputs | | | | | | | | |
| Self-Test | | 25×8 (2 | 200 Bits) | None | | | | |
| Accumulator | | 4 Bits | | | | | | |
| "Y" Register | | 4 Bits | | | | | | |
| "X" Register | | | 2 Bits | | | | | |
| Instruction Set | | | See Table 4 | | | | | |
| External Address Lines | | No | ne | 10 | | | | |
| On-Chip Oscillator | | | Yes | | | | | |
| Maximum | 5 V, 600 kHz | | 12 5 mW | | | | | |
| Power | 5 V, 100 kHz | 3 0 mW | | | | | | |
| Dissipation | 3 V, 200 kHz | | 15 mW | | | | | |
| Dissipation | 3 V , 30 kHz | 0 36 mW | | | | | | |

CMOS LSI

(LOW-POWER COMPLEMENTARY MOS)

ONE-CHIP MICROCOMPUTERS



MAXIMUM RATINGS (Voltages referenced to VSS)

| Rating | Symbol | Value | Unit |
|--------------------------------------|------------------|----------------------------|------|
| DC Supply Voltage | V _{DD} | -05 to +65 | ٧ |
| Input Voltage, All Inputs | V _{in} | -05 to V _{DD} +05 | ٧ |
| DC Current Drain per Pin, All Inputs | l I | 10 | mΑ |
| DC Current Drain, VDD Pin | 1 | 250 | mΑ |
| DC Current Drain, VSS Pin | 1 | 20 | mΑ |
| Operating Temperature Range | TA | -40 to +85 | °C |
| Storage Temperature Range | T _{stq} | -65 to +150 | °C |
| Total Power Dissipation | PD | See Figure 1 | mW |

RECOMMENDED OPERATING CONDITIONS (Vsc=0)

| Parameter | Symbol | Vaue | Unit |
|---|-----------------|----------------------------|------|
| DC Supply Voltage High Speed Clock Full Range Operation | V _{DD} | +4 75 to +60 +30 to +60 | ٧ |
| Clock Frequency V _{DD} = 5 0 V ±5% V _{DD} = 3 0 V Min | fCLK | DC to 600 DC to 200 | kHz |

This device contains circuitry to protect the inputs against damage due to high static voltages or electric fields, however, it is advised that normal precautions be taken to avoid application of any voltage higher than maximum rated voltages to this high-impedance circuit. For proper operation it is recommended that V_{1n} and V_{Out} be constrained to the range $VSS \leq (V_{1n})$ or $V_{Out} | \leq VDD$. Although internal pulldown resistors are used, it is recommended that all unused inputs be tied to an appropriate logic level (e.g., either VSS or VDD).

MC141000/MC141200 ONLY

DC ELECTRICAL CHARACTERISTICS (VDD = +5 Vdc ±5%, VSS = 0 V, unless otherwise noted)

| Characteristic | Symbol | T _A = 0 to 70°C | | | $T_A = -40 \text{ to } 85^{\circ}\text{C}$ | | l | |
|---|------------------------------------|----------------------------|----------------|--------------|--|--------------|------|--|
| Characteristic | Symbol | Min | Тур | Max | Min | Max | Unit | |
| Input Current $-$ K Inputs and INIT $V_{In} = 5~0~V$ $V_{In} = 0~0~V$ | l _{in} | 35 - | 100 - 0 005 | 165 - 1 0 | 30 - 0 005 | 215 - 1 0 | μΑ | |
| Input Voltage | V _{IL} V _{IH} | 3 6 | - | 1 4 | - 36 | 1 4 - | ٧ | |
| Output Drive — R and O Outputs (V _{OL} = 0 4 V, V _{DD} = 4 75 V) (V _{OH} = 2 4 V) — See Figure 1 | loh loh | _ _ 15 | | 1 6 — | - | 1 5 - | mΑ | |
| Average Supply Current | ^I DD | T - | - | See Figure 6 | - | See Figure 6 | mA | |
| Static Supply Current | ^I DD | T - | - | See Figure 2 | - | See Figure 2 | μΑ | |
| Oscillator Frequency (V _{DD} = 4 75 V) | fCLK | DC | - | 600 | DC | 600 | kHz | |
| Internal Oscillator Frequency for $R_{ext} = 25 \text{ k}\Omega$ | fCLK | 400 | 500 | 600 | 400 | 600 | kHz | |

MC141099 ONLY

DC ELECTRICAL CHARACTERISTICS (VDD = +5 0 Vdc, VSS = 0 V, TA = 25°C unless otherwise noted)

| Characteristic | Symbol | Min | Тур | Max | Unit |
|---|------------------------------------|--------------|------------------------|--------------|------|
| Input Current $-$ K Inputs and INIT ($V_{IR} = 5 \ 0 \ V$) ($V_{IR} = 0 \ 0 \ V$) | lin | 65 - | 100 - 0 00001 | 140 - 0 3 | μА |
| Input Current — Inputs (V _{In} = 5 0 V) (V _{In} = 0 0 V) | l _{in} | - | - 0 00001 - 0 00001 | 0 3 -0 3 | μΑ |
| Input Voltage - I Inputs | V _{IL} V _{IH} | 20 | _ | 08 | V |
| Input Voltage - Other Inputs | VIL VIH | _ 36 | _ | 1 4 - | ٧ |
| Output Drive — R and O Outputs (VOH = 2 4 V) (See Figure 1) (VOL = 0 4 V) | IOH IOI | - 15 1 6 | | -12 - | mA |
| Output Drive $-$ PA and PC Outputs (VOH = 4 6 V) (VOL = 0 4 V) | IOH IOL | - 100 100 | - | | μΑ |
| Average Supply Current | IDD | | | See Figure 6 | μΑ |
| Static Supply Current | lDD | | _ | See Figure 2 | μΑ |
| Oscillator Frequency (VDD=4 75 V) | fCLK | DC | | 600 | kHz |
| Internal Oscillator Frequency for $R_{ext} = 25 \text{ k}\Omega$ | fCLK | 400 | 500 | 600 | kHz |
| Input Capacitance - K Inputs and INIT | C _{in} | - | - | 75 | рF |
| Input Capacitance - Clock Input | C _{in} | - | _ | 30 | pF |

PIN ASSIGNMENTS

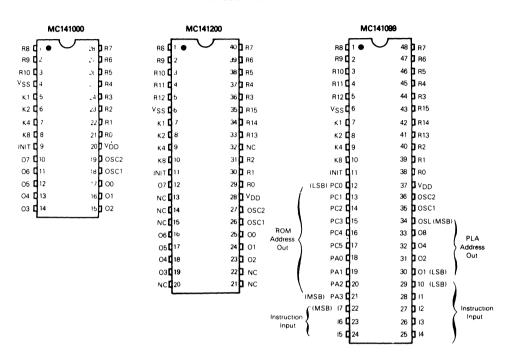


FIGURE 1 — MINIMUM OUTPUT SOURCE CURRENT versus OUTPUT VOLTAGE (R AND O OUTPUTS)

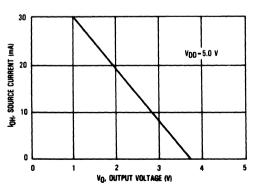


FIGURE 2 — POSITIVE SUPPLY VOLTAGE versus STATIC SUPPLY CURRENT

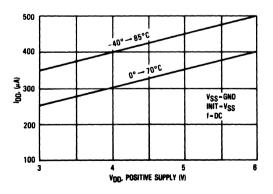
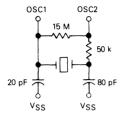


FIGURE 3 — EXTERNAL COMPONENTS FOR QUARTZ CRYSTAL OR CERAMIC RESONATOR OSCILLATOR



Component values typical for 500 kHz crystal

FIGURE 4 - EXTERNAL CLOCK SOURCE INPUT



FIGURE 5 — OSCILLATOR CIRCUIT WITH ONE EXTERNAL RESISTOR



FIGURE 6 — MAXIMUM OPERATING CURRENT Versus OSCILLATOR FREQUENCY

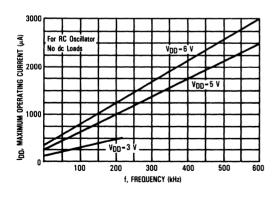
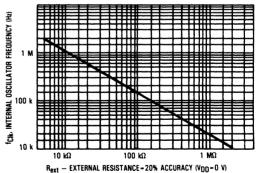


FIGURE 7 — TYPICAL OSCILLATOR FREQUENCY versus EXTERNAL RESISTANCE



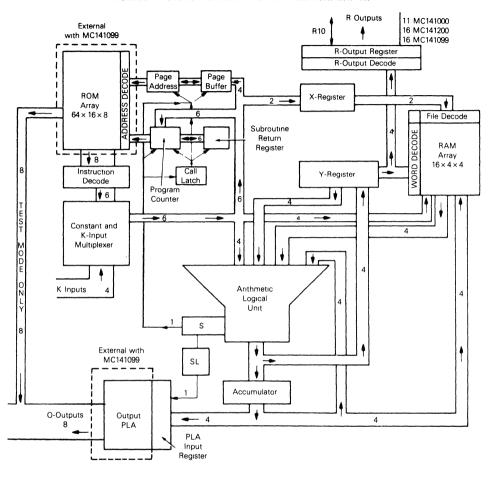


FIGURE 8 - FUNCTIONAL BLOCK DIAGRAM - MC141000/1200/1099

FUNCTIONAL BLOCKS

Figure 8 shows a block diagram of the resources available to the MC141000/1200/1099 programmer They are

A The accumulator is used to store the result of an ALU operation for subsequent operations
ALU The arithmetic logical unit performs calcula-

ALU The arithmetic logical unit performs calculation and decision-making tasks

K Inputs The K lines are the data input port. Since there are only four input lines, they are usually multiplexed under control of the R lines using

external hardware. The inputs are diode protected and have a pulldown resistor of approximately 50k ohms, therefore, open inputs are read as a logic low.

O Outputs

The eight outputs of the PLA are connected to output drivers which comprise the O-outputs.

These output drivers may be manufactured as open-emitter, open-drain, or push-pull at the user's option.

PLA The output programmable logic array is maskprogrammable to specify the state of each of the eight O-outputs for each of the 32 possible PLAIR outputs

PLAIR The programmable logic array input register is a 5-bit latch which latches the four accumulator bits and the output of the status latch

RAM Variable data is stored in the 64-word, 4-bitper-word random-access memory Data is accessed by decoding a 2-bit file address (X register) and 4-bit word address (Y register)

The user's instructions are mask programmed into the read-only memory (ROM) Instructions are addressed by a page address register (PA) and program counter (PC) A single subroutine return register (SRR) and page buffer register (PB) permit subroutine calls to any location within the ROM

ROM Array

MC141000 • MC141200 • MC141099

R Outputs

The output of the Y register is decoded to

| then be set The R-lines keyboards ar and interfact may be man | or rese are used nd displa ce exter ufacture | R-output line t under pro d as control ays, perform rnal bit Th ed as open-e | gram control lines to scan handshakes, ne R-outputs emitter, open- | where the Sarine crult may be used not several applications. Since the K-inputs have 50k pulldown resistors, they will be a "0" (unless driven from another device) and the 1's complement (F) will be loaded into PA and PB. After power-up or initialization, instruction execution will continue sequentially within the specified ROM page unless interrupted by a branch, subroutine call, subroutine return or another initialization. INIT may be used as an interrupt pir since it will execute the program from the ROM page specified by the K-inputs. The interrupting device must force the desired ROM page in 1's complement format on the K-inputs. No previous program information will be stored as in classical interrupts, however, program control can be altered via external hardware. | | | | | | | |
|---|---|---|--|--|--|--|--|--|--|--|--|
| dent on the s | state of ton logical | the status bit al or arithme | b3 It may be tic operations | | | | | | | | |
| logic in orde | er to pr | reserve it fo | | | | | | | | | |
| | | | | ARITHME | TIC LOGICAL UNIT (ALU) | | | | | | |
| | | | | | U is the calculating and decision-making protion of | | | | | | |
| Y Register The 4-bit Y register is a multipurpose register used to address a word in a RAM file, to select an R-output for manipulation by subsequent | | | | | the MC141000 and consists of a 4-bit adder/comparator an the status bit The status bit will be selectively set or reset by add, sub- | | | | | | |
| | | | | | | | | | | | |
| | | s used to ac | ddress one of | The adder/comparator can add, subtract, compare tw numbers, add $+ 1$, $- 1$, 6 , 8 , and 10 | | | | | | | |
| The page ac | ldress re | egister is us | ed to address | The arit | hmetic instructions are | | | | | | |
| one of 16 ROM pages | | | AMAAC | Add memory to accumulator, results to ac- | | | | | | | |
| | | | | CANAAN | cumulator Carry to status | | | | | | |
| | | | | SAMAN | Subtract accumulator from memory, results to accumulator. If no borrow, one to status | | | | | | |
| page | 211011 00 | 10000 01 1110 | carrent mon | IMAC | Load memory into accumulator, increment ac- | | | | | | |
| | | | | ,,,,,,, | cumulator Carry to status | | | | | | |
| | | | | DMAN | Load memory into accumulator, decrement ac- | | | | | | |
| | | | | 1.0 | cumulator If no borrow, one to status Increment accumulator, no status effect | | | | | | |
| | | | | | | | | | | | |
| | | | | | Increment Y register Carry to status Decrement accumulator If no borrow, one to | | | | | | |
| | | | T 11 4 | DAN | status | | | | | | |
| When power is applied, the registers shown in Table 1 are oaded as shown for power-up. All other internal registers | | | | DYN | Decrement Y register If no borrow, one to status | | | | | | |
| | | | TION | A8AAC | Add 8 to accumulator, results to accumulator Carry to status | | | | | | |
| PC PA | РВ | CL PLAIR | R-Outputs | A10AAC | Add 10 to accumulator, results to accumulator Carry to status | | | | | | |
| 0 15 | 15 | 0 0 | 0 | A6AAC | Add 6 to accumulator, results to accumulator | | | | | | |
| 0 <u>K</u> | K | 0 0 | 0 | 0 | Carry to status | | | | | | |
| | | | | CPAIZ | Complement accumulator and increment life zero, one to status | | | | | | |
| | | | | The log | ical instructions are | | | | | | |
| | | | | ALEM | If accumulator less than or equal to memory, | | | | | | |
| | then be set The R-lines keyboards at and interfac may be man drain, or pus All branches set or reset of and is set by The state lat logic in ordination of the set of the state lat logic in ordination of the set of the state lat logic in ordination of the state lat logic in ordination of the state lat logic in ordination of the state lat logic in ordination of the state lat logic in ordination of the state lat logic in ordination of the state lat logic in ordination of the state late logic in ordination of the state late late late late late late late | then be set or rese The R-lines are use keyboards and displ and interface exte may be manufacture drain, or push-pull a All branches and su dent on the state of- set or reset on logic and is set by the rem The state latch latch logic in order to pi O-output operations NOTE S and SL ai The 4-bit Y register used to address a we an R-output for ma instructions, or as a and storage register This 2-bit register is four RAM files The page address in one of 16 ROM pag The page buffer in subroutine return re calls and branch ou page The subroutine return re calls and branch ou page The call latch is use or subroutine call ha accesses beyond the AND INITIALIZATION wer is applied, the reginown for power-up orne up in an arbitrary SEE 1 — POWER-UP AN PC PA PB 0 15 15 0 K K | then be set or reset under profite R-lines are used as control keyboards and displays, perform and interface external bit. The may be manufactured as opendrain, or push-pull at the user's All branches and subroutine call dent on the state of the status bir set or reset on logical or arithme and is set by the remainder of the The state latch latches the state logic in order to preserve it for O-output operations. NOTE S and SL are NOT iden. The 4-bit Y register is a multipulused to address a word in a RAM an R-output for manipulation be instructions, or as a general purpand storage register. This 2-bit register is used to acfour RAM files. The page address register is used to acfour RAM files. The page address register is used to acfour RAM files. The page buffer register is usured to a four RAM files. The page address from a subroutine return register to pericalls and branch outside of the page. The subroutine return register to pericalls and branch outside of the page. The subroutine call has to use the laccesses beyond the current RC AND INITIALIZATION. 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All other internal registers one up in an arbitrary state ILE 1 — POWER-UP AND INITIALIZATION PC PA PB CL PLAIR R-Outputs 0 15 15 0 0 0 0 0 0 Ver is applied, the initialize (INIT) input may be initialize the processor Internally, INIT has a alldown resistor which holds the INIT line low. It | then be set or reset under program control The R-lines are used as control lines to scan keyboards and displays, perform handshakes, and interface external bit The R-outputs may be manufactured as open-emitter, open- drain, or push-pull at the user's option All branches and subroutine calls are depen- dent on the state of the status bit b3. It may be set or reset on logical or arithmetic operations and is set by the remainder of the instructions. The state latch latches the state of the status logic in order to preserve it for subsequent O-output operations NOTE. S. and S.L. are NOT identical The 4-bit Y register is a multipurpose register used to address a word in a RAM file, to select an R-output for manipulation by subsequent instructions, or as a general purpose counting and storage register This 2-bit register is used to address one of four RAM files The page address register is used to address one of 16 ROM pages The page buffer register is used to address one of 16 ROM pages The page buffer register is used to totore the return address from a subroutine calls and branch outside of the current ROM page The subroutine return register is used to store the return address from a subroutine The call latch is used to determine if a branch or subroutine call has to use the PA and PB for accesses beyond the current ROM page AND INITIALIZATION Wer is applied, the registers shown in Table 1 are mown for power-up. 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must be held high for a minimum of 6 full clock cycles and then returned to the low state. If a mechanical switch or other mechnical device is used to control INIT, it may be necessary to include a method of contact debounce to ensure a valid INIT pulse

A valid INIT pulse will cause the registers to be loaded as shown in the table. The contents of registers other than those shown will remain unchanged during initialization Note that the PA and PB are loaded with the 1's complement of the K-input lines (K8=MSB) This feature allows the MC141000 to be initialized to the first instruction on any page by controlling the K-inputs during initialization. This is useful

where the same circuit may be used for several applications

| AMAAC | Add memory to accumulator, results to accumulator Carry to status |
|-------|--|
| SAMAN | Subtract accumulator from memory, results to accumulator If no borrow, one to status |
| IMAC | Load memory into accumulator, increment accumulator. Carry to status |
| DMAN | Load memory into accumulator, decrement accumulator. If no borrow, one to status |
| IA | Increment accumulator, no status effect |
| IYC | Increment Y register Carry to status |
| DAN | Decrement accumulator If no borrow, one to |

one to status

ALEC If accumulator less than or equal to a constant, one to status

KNEZ If K-inputs not all zero, one to status MNEZ If memory not equal to zero, one to status TBIT1 If the selected bit is one, one to status

YNEA If Y register not equal to accumulator, one to status and status latch

YNEC If Y register not equal to a constant, one to status

INSTRUCTION DECODE

The instruction decode logic latches every instruction fetched from ROM and configures the internal logic to correctly execute the current instruction. The MC141000 includes within the instruction-decode logic the capability of modifying the standard instruction set. Typical examples of useful nonstandard instructions are

SRDY Set R-Output and decrement Y

TDOIY Transfer A and SL to PLAIR and increment Y Transfer K inputs to memory and increment the TKM

Y Register

ANFM A not equal to M (X, Y)

The factory should be consulted for feasibility of specific instruction-set modifications

RANDOM ACCESS MEMORY - RAM

RAM consists of 256-bits organized into 64 4-bit words For purposes of addressing, the 4-bit words are organized into four files of 16 4-bit words per file (see Figure 9)

The X register is decoded to select one of the 4 RAM files, and the Y register is decoded to address one of the 16 words in the selected file

Instructions which can be used to address the RAM file are the LDX which loads the X register from ROM, and the COMX instruction which complements the X register. The Y register can be loaded from ROM (TCY), from RAM (TMY). or the accumulator (TAY). The Y register can also be incremented (IYC, TCMIY, and TAMIY) and 'decremented (DYN)

Individual bits within the RAM can be set (SBIT), reset (RBIT), and tested (TBIT1) under program control. The RAM word to be operated on is defined by the X and Y registers, and the 2-bit B field of the bit manipulation instruction selects the bit to be operated on (see Table 4)

Instructions which directly access RAM are

ALEM Accumulator less than or equal to memory

AMAAC Add memory to accumulator, store result in accumulator

Load accumulator with decremented memory

DMAN

contents IMAC Load accumulator with incremented memory

contents

MNEZ Compare for memory not equal to zero

SAMAN Subtract the accumulator from the memory and

store the result in the accumulator

TAM Transfer accumulator to memory -

TAMIY Transfer accumulator to memory, increment Y register

TAMZA Transfer accumulator to memory, load the ac-

cumulator with zero TMA

Transfer memory to accumulator TMY Transfer memory to Y register **XMA** Exchange memory and accumulator

Since the Y register is an integral part of the memory addressing scheme, Y register manipulation instructions are important to RAM. The Y register can be changed by the following instructions

IYC Increment the Y register DYN Decrement the Y register TAY Transfer accumulator to Y register TCY Load the Y register with a constant.

TMY Transfer memory to Y register

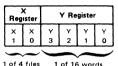
TAMIY Transfer accumulator to memory, incremented

to Y register

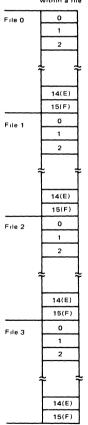
TCMIY Transfer constant to memory, increment Y

register

FIGURE 9 - RAM ORGANIZATION



1 of 16 words within a file



4 Bits/Word

ROM ARRAY

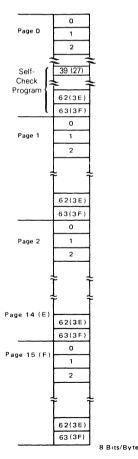
The ROM consists of 8192-bits of mask-programmed memory organized as 1024 8-bit instructions. It is divided into 16 pages of 64 instructions per page. The self-test program is located in the last 25 bytes of page 0. These 25 bytes are not available for user programs, therefore, only 999 bytes are available for the user instructions. See the Self-Test section for a detailed description.

FIGURE 10 - ROM ORGANIZATION

| Page Address | | | | Program Counter | | | | | | | |
|--------------|----|----|----|-----------------|----|----|----|----|----|--|--|
| PA | PA | PA | PA | PC | PC | PC | PC | PC | PC | | |
| 3 | 2 | 1 | 0 | 5 | 4 | 3 | 2 | 1 | 0 | | |

1 of 16 pages

1 of 64 bytes within a page



Instructions within ROM are addressed by the page address register (PA) which contains the page number, and the program counter (PC) which contains the location of the instruction relative to the beginning of the page. The PC is incremented prior to fetching the next instruction (unless diverted by a Branch or Call) so each instruction is accessed in the numerical order of its address. A carry from the PC is not added to the PA so the program will "wraparound" within the page rather than executing the first instruction of the following page. Upon power-up, the PC is set to zero and the PA and PB are set to 15

INPUTS

The input lines consist of the four K-input lines and the initialize (INIT) line. All inputs are static-protected CMOS inputs with pulldown of about 50 k Ω . Thus, an open input is equivalent to logic 0. The circuit is shown in Figure 15.

- KNEZ If the K input lines are not equal to zero, set the status logic to one
- TKA Transfer the contents of the four input lines to the accumulator

Operation of the INIT is described previously (Table 1)

OUTPUT PORTS

Two output ports (R and O) are included in the microcomputer. The MC141000 has 11 R-outputs and the MC141200 has 16 R-outputs and both machines have eight O-outputs. The number of R-outputs is the only difference between the MC141000 and the MC141200.

R-output lines are used primarily as control or "hand-shake" lines, and to multiplex external hardware. The R-output which is to be operated on is selected by a binary decode of the contents of the Y register and is set by the SETR instruction and reset RSTR instruction.

The eight O-output lines are the decoded output of the contents of the 5-bit PLAIR Since the PLAIR is loaded from the A and the SL, these registers must be "setup" prior to an output operation. The status latch can only be loaded by the YNEA (Y register not equal to accumulator) instruction while the contents of the accumulator may be modified by numerous other instructions.

The O output instructions are

TDO - Transfer data from the accumulator and status latch to the PLAIR

CLO - Clear PLAIR, I e , load with zeros

In a typical application, the first four R lines might be used as digit selects for outputting a four-digit decimal number using the PLA programmed as a seven-segment decode as shown in Figure 11. The software needed to accomplish this task is shown in the application sections.

OUTPUT CONFIGURATIONS

The MC141000/1200 outputs may be mask programmed in any of three configurations. Figure 12 shows the open-emitter configuration capable of sourcing 15 mA at V $_{\rm O}=2$ 4 V and V $_{\rm DD}=5$ 0 V, which will drive an LED. Figure 14 is the open-drain configuration capable of sinking 1.6 mA over temperature, which will drive one TTL load or four LSTTL loads. The source and sink devices are combined in the active push-pull configuration of Figure 13. The MC141099 also has outputs as in Figure 13.

FIGURE 11 - OUTPUT PLA EXAMPLE - 7-SEGMENT DISPLAY DECODE

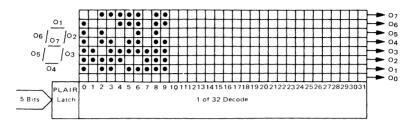


FIGURE 12 - OPEN-EMITTER OUTPUT CIRCUIT

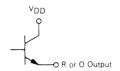


FIGURE 13 — ACTIVE PUSH-PULL OUTPUT CIRCUIT (DEFAULT CONFIGURATION)

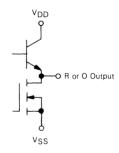


FIGURE 14 - OPEN-DRAIN OUTPUT CIRCUIT

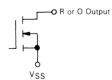
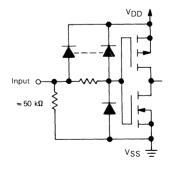


FIGURE 15 — INPUT CIRCUIT WITH PULLDOWN AND STATIC PROTECTION



MC141000/MC141200 SELF-TEST

The self-test routine tests the RAM, K-inputs, R-lines, O-outputs, accumulator, status latch, status bit, X register, and Y-register The self-test program will load the value obtained from the K-input into RAM beginning at (0-15) Four load loops are made Each R-line is set and reset as the Y-register is decremented RAM is then sequentially dumped to the O-outputs. The self-test program is located in the last 25 bytes of page 0 in the instruction ROM (see Figure 10).

To execute the self-test routine, perform the following after power-on reset

- 1 Force INIT, R10, and all K-inputs high
- 2 Clock 6 times
- 3 Pull INIT low
- 4 Clock 6 times
- Word zero of ROM page zero will be output on the O-outputs
- 6 ROM will be dumped sequentially as the chip is clocked
- 7 Dump up to word 39 and pull R10 low
- 8 Load K-inputs with pattern for RAM
- 9 Allow the clock to free-run to let self-test program begin execution

EMULATION

The MC141000/MC141200 can be emulated using the MC141099 and system external memory. The example system shown in Figure 16 uses MCM2708's to emulate the instruction ROM (999 bytes are needed) and the PLA (only 32 bytes are needed) The MC141099 outputs are not mask programmable and are active push-pull. The user must add buffers to simulate other output driver configurations.

STATUS AND STATUS LATCH

All program-modifying instructions (BRanch or CALL) are conditional on the state of the status bit If status is set, the BRanch or CALL is executed by jumping to the ROM address specified by the operand field of the BRanch or CALL instruction and the contents of the page buffer register (PB) If status is reset, the BRanch or CALL is not to be taken, and the instruction following the BRanch or CALL is the next to execute The BRanch or CALL takes six clock cycles (one instruction cycle) to execute whether the status is set or reset

The status bit is normally set. Whenever it is reset, the reset condition only lasts for one instruction cycle and then returns to the set state. The only means to keep it reset for

MC141000 SELF-TEST

ROUTINE TO TEST RAM, K INPUTS, R-LINES, O-OUTPUTS, ACCUMULATOR, STATUS LATCH, X-REG, Y-REG, STATUS LOGIC (CONDITIONAL BR AND CALL)

ROUTINE NOT ACCESSED BY NORMAL PROG EXEC

| 4F 3C | 01001111 00111100 | | TCY LDX | 15 0 |
|----------|----------------------|--------|------------|---------|
| EB | 11101011 | | CALL | FILL |
| 00 | 00000000 | COMFIL | COMX | |
| 08 | 00001000 | FILL | TKA | |
| 0D | 00001101 | | SETR | |
| OC | 00001100 | | RSTR | |
| 04 | 00000100 | | TAMZA | |
| 2C | 00101100 | | DYN | |
| AB | 10101011 | | BR | FILL |
| 0F | 00001111 | | RETN | |
| 3E | 00111110 | | LDX | 1 |
| EB | 11101011 | | CALL | FILL |
| EA | 11101010 | | CALL | COMFIL |
| 02 | 00000010 | DUMP1 | YNEA | |
| 00 | 00000000 | COMDMP | COMX | |
| 21 | 00100001 | DUMP | TMA | |
| 0A | 00001010 | | TDO | |
| 2C | 00101100 | | DYN | |
| B7 | 10110111 | | BR | DUMP |
| 0F | 00001111 | | RETN | |
| F6 | 11110110 | | CALL | COMDMP |
| 23 | 00100011 | | TYA | |
| 3C | 00111100 | | LDX | 0 |
| B5 | 10110101 | | BR PAGE | DUMP1 |
| | | | | |

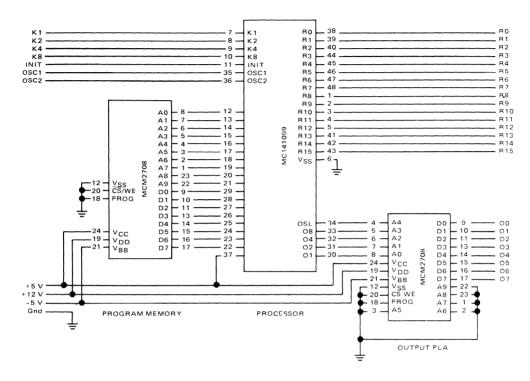


FIGURE 16 - USING THE MC141099 TO EMULATE THE MC141000/MC141200 IN REAL-TIME

NOTE The OPLA EPROM outputs may require buffers depending on the requirements of the user's circuit.

The EPROM outputs are TTL compatible

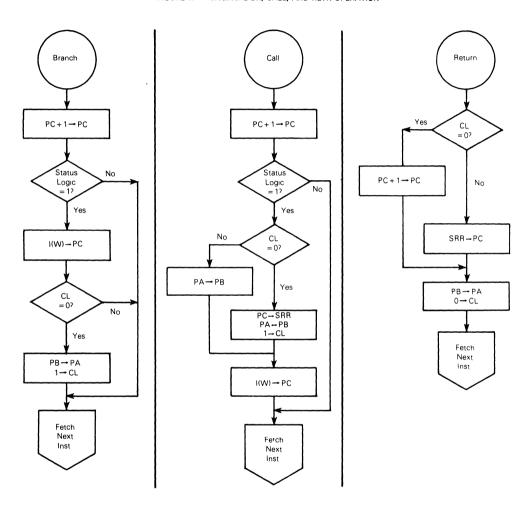
more than one instruction cycle is to execute more than one instruction in series which causes it to reset in series

The status latch takes the state of the status logic and saves it during the execution of a YNEA instruction Therefore, a YNEA instruction must be executed before a TDO instruction to ensure that the desired state of status latch is placed into the PLA input register.

BRANCH, CALL AND RETURN OPERATIONS FIGURE 17

The normal sequence of instruction execution may be diverted by branch (BR) or subroutine call (CALL) instructions which are conditional on the state of the status bit. If the status equals one, the BR or CALL will be executed. If the status bit is zero the instruction following the BR or CALL will be executed.

FIGURE 17 - INTERNAL BR, CALL, AND RETN OPERATION



BR (BRANCH) — A successful BR causes the PC to be loaded from the last six bits I (W) of the BR instruction. If the call latch (CL) is zero, the PA will also be loaded from the PB, however, if the CL is one, the PA will not be altered.

A load page (LDP) instruction can be used prior to a BR to cause program control to be transferred anywhere within the ROM

NOTE

A BR within a subroutine CALL is limited to a short branch within the same page in order to preserve the subroutine return address

CALL — The CALL instruction permits the use of subroutines in MC141000 programs. The successful CALL instruction causes.

- 1 the PC to be incremented and stored in the subroutine return register (SRR),
- 2 the PC to be loaded from the six least-significant bits of the CALL instruction,
- 3 the call latch (CL) to be set to one, and
- 4 the PB to be exchanged with the PA

Since there is a single level of subroutine-return-address storage, nested subroutines are not permitted. A CALL within a subroutine will cause the return PB to be loaded with the PA. Branch instructions beyond the current page are not permitted within a subroutine since the PB is used as the storage register for the subroutine return page address.

RETN — The return from subroutine instruction (RETN) causes the PC to be loaded from the SRR, the PA to be loaded from the PB, and the CL to be reset

BR AND CALL SUMMARY — FIGURE 18 — The conditions imposed on Branch and Call intructions are

- 1 they will only be executed when status is set,
- 2 a long BR or CALL off the current page will result if the PB is loaded by an LDP instruction prior to execution of the BR or CALL,
- 3 only branches within the current page are allowed within a subroutine, and
- 4 instruction execution requires six clock cycles whether or not the BR or CALL was successful

FIGURE 18 - BR, CALL, AND RETN SUMMARY

| Instruction | Status Logic | Call Latch | Action |
|--------------------------|-----------------|---------------|---|
| BR | 1 | 0 | I(W) → PC, PB → PA |
| (Branch) | 1 | 1 | I(W) → PC |
| (Branch) | 0 | X | PC+1→PC, 1→Status |
| CALL | 1 | 0 | PC+1→SRR, I(W)→PC, PA↔PB, 1→CL |
| CALL | 11 | 1 | I(W) → PC, PA → PB |
| (Call Subroutine) | 0 | Х | PC+1→PC, 1→Status Logic |
| RETN | × | 1 | $SRR \rightarrow PC$, $PB \rightarrow PA$, $0 \rightarrow CL$ |
| (Return from Subroutine) | X | 0 | PC+1→PC, PB→PA |

X = Don't Care

PA = Page Address Register

PB = Page Buffer

PC = Program Counter

SRR = Subroutine Return Register

CL = Call Latch

I(W) = 6 Least-Significant Bits of a Call or BR

INSTRUCTION TABLES

The MC141000 microcomputer instruction set consists of 43 standard instructions. These are summarized in Table 3,

which lists the instructions by function, and Table 4 which lists the instructions alphabetically

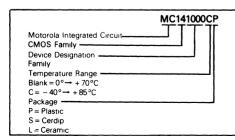
TABLE 3 - MC141000/1200 INSTRUCTION SET, FUNCTION LIST

| Function | Mnemonic | Condition Setting Status | Action |
|--------------|----------|--|--|
| ROM | BR | Always | See Figure 18 |
| Addressing | CALL | Always | See Figure 18 |
| | LDP | Always | I(C) → PB |
| | RETN | Always | See Figure 18 |
| RAM X | COMX | Always | X→X |
| Addressing | LDX | Always | I(B) → X |
| Output | CLO | Always | O→PLAIR |
| | RSTR | Always | O → R(Y) |
| | SETR | Always | 1→R(Y) |
| | TDO | Always | SL,A→PLAIR |
| Input | KNEZ | K-Inputs not zero | K≠0 |
| | TKA | Always | K→A |
| Internal | CLA | Always | 0→ A |
| Data | TAM | Always | $A \rightarrow M(X,Y)$ |
| Transfer | TAMIY | Always | $A \rightarrow M(X,Y), Y + 1 \rightarrow Y$ |
| | TAMZA | Always | $A \rightarrow M(X,Y), 0 \rightarrow A$ |
| | TAY | Always | A→Y |
| | TCY | Always | I(C) → Y |
| | TCMIY | Always | $I(C) \rightarrow M(X,Y), Y+1 \rightarrow Y$ |
| | TMA | Always | $M(X,Y) \rightarrow A$ |
| | TMY | Always | $M(X,Y) \rightarrow Y$ |
| | TYA | Always | Y→A |
| | XMA | Always | $M(X,Y) \leftrightarrow A$ |
| Bit | RBIT | Always | 0→ M(X,Y,B) |
| Manipulation | SBIT | Always | 1 → M(X,Y,B) |
| | TBIT1 | Bit equal to 1 | M(X,Y,B) = 1 |
| Arithmetic | A6AAC | Carry | A+6→ A |
| | A8AAC | Carry | A+8→A |
| | A10AA | Carry | A + 10 → A |
| | AMAAC | Carry | $M(X,Y) + A \rightarrow A$ |
| | CPAIZ | Carry | A+1→A |
| | DAN | Carry | A – 1 → A |
| | DMAN | Carry | M(X,Y) – 1 → A |
| | DYN | Carry | Y – 1 → Y |
| | IA | Always | A+1→A |
| | IMAC | Carry | M(X,Y) + 1 → A |
| | IYC | Carry | Y + 1 → A |
| | SAMAN | If no borrow | $M(X,Y) - A \rightarrow A$ |
| Logical | ALEC | Accumulator less than or equal to constant | A≤(C) |
| Ü | ALEM | Accumulator less than or equal to memory | $A \leq M(X,Y)$ |
| | MNEZ | Memory not equal to zero | M(X,Y)≠0 |
| | YNEA | Y-Register not equal to accumulator | Y≠A,S→SL |
| | YNEC | Y-Register not equal to constant | Y ≠ (C) |

TABLE 4 - MC141000/1200/1099 INSTRUCTION SET

| Opcode | Mnemonic | Description |
|------------|----------|--|
| 0111 (C) | ALEC | If accumulator is less than or equal to I(C) field, status = 1 |
| 00101001 | ALEM | If accumulator is less than or equal to $M(X,Y)$, status = 1 |
| 00100101 | AMAAC | Add memory to accumulator Accumulator = result, status = carry |
| 00000110 | A6AAC | Add 6 to accumulator Accumulator = result, status = carry |
| 00000001 | A8AAC | Add 8 to accumulator Accumulator = result, status = carry |
| 00000101 | A10AAC | Add 10 to accumulator Accumulator = result, status = carry |
| 10(W) | BR | Branch to label if status = 1 |
| 11(W) | CALL | Call subroutine if status = 1 |
| 00101111 | CLA | Clear contents of accumulator |
| 00001011 | CLO | Clear PLA Input Register |
| 00000000 | сомх | Complement X-Register |
| 00101101 | CPAIZ | Complement accumulator, then add 1 If accumulator = 0, status = 1 |
| 00000111 | DAN | Decrement accumulator If no borrow, status = 1 |
| 00101010 | DMAN | Load M(X,Y) into accumulator and decrement. If no borrow, status = 1 |
| 00101100 | DYN | Decrement Y-register If no borrow, status = 1 |
| 00001110 | IA | Increment accumulator |
| 00101000 | IMAC | Load M(X,Y) into accumulator and increment Status = carry |
| 00101011 | IYC | Increment Y-Register Status = carry |
| 00001001 | KNEZ | If K-inputs not equal to zero, status = 1 |
| 0001 (C) | LDP | Load page buffer with I(C) field |
| 001111 (B) | LDX | Load X-register with I(B) field |
| 00100110 | MNEZ | If M(X,Y) not equal to zero, status = 1 |
| 001101 (B) | RBIT | Reset bit I(B) of M(X,Y) |
| 00001111 | RETN | Return from subroutine |
| 00001100 | RSTR | Reset R-line specified by Y-register |
| 00100111 | SAMAN | Subtract accumulator from memory Accumulator = result If no borrow, status = 1 |
| 001100 (B) | SBIT | Set Bit I(B) of M(X,Y) |
| 00001101 | SETR | Set R-line specified by Y-register |
| 00000011 | TAM | Transfer accumulator contents to M(X,Y) |
| 00100000 | TAMIY | Transfer accumulator contents to M(X,Y), increment Y-register |
| 00000100 | TAMZA | Transfer accumulator contents to M(X,Y), zero accumulator |
| 00100100 | TAY | Transfer accumulator contents to Y-register |
| 001110 (B) | TBIT1 | If bit I(B) of M(X,Y) is one, status=1 |
| 0100 (C) | TCY | Transfer I(C) field to Y-register |
| 0110 (C) | TCMIY | Transfer I(C) field to M(X,Y), increment Y-register |
| 00001010 | TDO | Transfer status latch and accumulator to PLA input register |
| 00001000 | TKA | Transfer K-inputs to accumulator |
| 00100001 | TMA | Transfer M(X,Y) to accumulator |
| 00100010 | TMY | Transfer M(X,Y) to Y-register |
| 00100011 | TYA | Transfer Y-register contents to accumulator |
| 00101110 | XMA | Exchange contents of M(X,Y) and accumulator |
| 00000010 | YNEA | If Y-register is not equal to accumulator, status and status latch = 1 |
| 0101 (C) | YNEC | If Y-register is not equal to I(C) field, status = 1 |

ORDERING INFORMATION



BETTER PROGRAM

Better program processing is available on all types listed. Add suffix letters to part number.

Level 1 add "S" Level 2 add "D" Level 3 add "DS"

Level 1="S" = 10 Temp Cycles $- (-25 \text{ to } 150 \,^{\circ}\text{C})$, Hi Temp testing at T_{Δ} max

Level 2 "D" = 168 Hour Burn-in at 125°C

Level 3 "DS" = Combination of Level 1 and 2

MC141000/MC141200 TEST REQUIREMENTS AND SUBMITTAL FORMAT

TEST REQUIREMENTS

To test the MC141000 or MC141200 thoroughly and economically, it is necessary to reserve the twenty-five locations from page 0, address 27 through page 0, address 3F Motorola will insert a test routine in these locations. If these locations are needed as part of the user's program, contact Motorola to discuss alternatives and additional costs

SUBMITTAL FORMAT

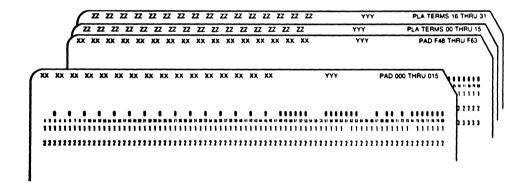
The required format for program submittal is either an MDOS compatible floppy disk or a Silent 700 compatible cassette containing the AF file from the Motorola assembler A card deck with Motorola object code is also acceptable

(The source code is standard but the object code is not standard among manufacturers.) See format below

There must be a total of sixty-six records (64 data records and 2 OPLA records) where "XX" are the instruction operation codes, "YYY" are the arithmetic sums of all "XX" and "ZZ" for that record, and "ZZ" are output PLA values (X, Y, and Z are hexadecimal)

Other media and formats (such as paper tape, EPROMS, paper listings, etc.) may be acceptable but may require extra charges for engineering time and will be handled on an individual basis

Use the MC141000 Program Submittal Form included in this data sheet with all program submittals



4

MC141000 PROGRAM SUBMITTAL FORM

| Device Type MC141000 N | MC141200 Ceramic | | | For Motoro | la Use Only |
|--|------------------------------------|-----------------|----------------------------|---------------------|-------------|
| | | | Mask# | | , |
| Customer Part # | | | MOT Part # | | |
| File Name | AF (from disk o | r cassette) | Layer # | | |
| Marking Desired | plus 4-digit | date code | Rec'd | | |
| R | AM utilization map (place X in eac | h cell used) | | | |
| | ANT CHIEGOTI THAP TPIACE X III CAE | The cent discut | | $\neg \Box$ | ٦ |
| 0 = X | + | | - $+$ $+$ $+$ $+$ | | _ |
| X = 1 | + | +++ | - | $\dashv +$ | 4 |
| X = 2 | | 444 | | | |
| X = 3 | | لـلــلــ | لــلــلــ | | ل |
| ¥ = 0 | Y Y = 5 = 6 = 7 | Y = 9 Y = 7 | Y = 12 Y = 11 Y = 10 | Y = 14 Y = 13 | |
| Output Configuration (cl | neck proper boxes) | | | | |
| | | Open Emitter | | Open Collector | |
| R0 | | Source) | | (Sink) | Unused |
| R1 | _ | | | | |
| R2 | _ | <u> </u> | | | |
| R3 | _ | <u> </u> | | | |
| R4 | | Π | | n. | |
| R5 | _ | <u> </u> | | | |
| R6 | _ | <u> </u> | | | |
| R7 | _ | <u> </u> | | | |
| R8 | | <u> </u> | | | |
| R9 | _ | <u> </u> | | $\overline{\Box}$. | |
| R10 | | <u> </u> | | | |
| R11 | . n | Π | | Π. | |
| 8 R12 | . 🛭 | <u> </u> | | | |
| MC14120 O o o o o o o o o o o o o o o o o o o o | _ | <u> </u> | | | |
| R14 | | <u> </u> | | <u> </u> | |
| R15 | 🗅 | <u> </u> | | <u> </u> | |
| 00 | | <u> </u> | | | |
| 01 | 🗅 | <u> </u> | | <u> </u> | |
| 02 | _ | | | | |
| 03 | | | | | |
| 04 | 🛭 | n | | | |
| 05 | 🛭 | | | | |
| 06 | 🖸 | | | | |
| 07 | _ | <u> </u> | | _ | |



Advance Information

8-BIT MICROPROCESSOR UNIT

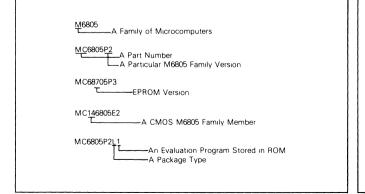
The MC146805E2 Microprocessor Unit (MPU) belongs to the M6805 Family of microcomputers. This 8-bit fully static and expandable microprocessor contains a CPU, on-chip RAM, I/O, and timer. It is a low-power, low cost processor designed for low-end to mid-range applications in the consumer, automotive, industrial, and communications markets where very low power consumption constitutes an important factor. The following are the major features of the MC146805E2 MPU.

Hardware Features:

- Typical Full Speed Operating Power of 35 mW @ 5V
- Typical WAIT Mode Power of 5 mW
- Typical STOP Mode Power of 25 μW
- 112 Bytes of On-Chip RAM
- 16 Bidirectional I/O Lines
- Internal 8-Bit Timer with Software Programmable 7-Bit Prescaler
- External Timer Input
- Full External and Timer Interrupts
- Multiplexed Address/Data Bus
- Master Reset and Power-On Reset
- Capable of Addressing Up to 8k Bytes of External Memory
- Single 3 to 6 Volt Supply
- On-Chip Oscillator
- 40-Pin Dual-In-Line Package
- Chip-Carrier Also Available

Software Features:

- Similar to the MC6800
- Efficient Use of Program Space
- Versatile Interrupt Handling
- True Bit Manipulation
- Addressing Modes With Indexed Addressing for Tables
- Efficient Instruction Set
- Memory Mapped I/O
- Two Power Saving Standby Modes

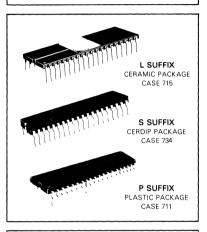


MC146805E2

CMOS

(HIGH PERFORMANCE SILICON GATE)

8-BIT MICROPROCESSOR



PIN ASSIGNMENTS RESET 40 UVDD **IRQ** 39 hosc1 LI**₫**3 38 hosc2 DST 4 37 TIMER R/Wd5 36 **1** PB0 AS d 6 35 PB1 34 **1** PB2 PA7 7 33 **Б**РВЗ PA6**□** 8 32 **1** PB4 PA5 19 PA4 10 31 DPB5 30 **T**PB6 PA3 11 PA2 12 29 PB7 PA1 13 28 **1** B0 PA0**1**14 27 B1 A12 15 26 B2 A11**1**16 25 **1** B3 A10**[**17 24 🗖 B4 A9 118 23 B5 A8**1**19 22 B6 V_{SS}**∏**20 21 DB7

MAXIMUM RATINGS (voltages referenced to VSS)

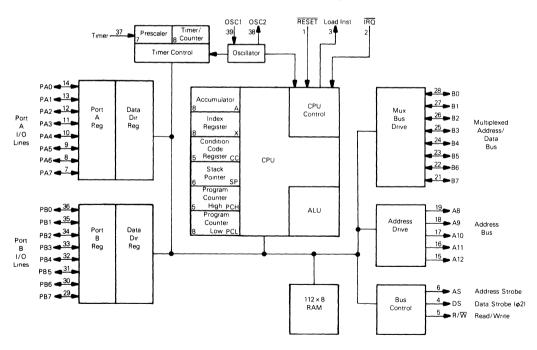
| Ratings | Symbol | Value | Unit |
|---|------------------|--|------|
| Supply Voltage | V _{DD} | -03 to +80 | V |
| All Input Voltages Except OSC1 | V _{in} | V _{DD} +05 to V _{SS} -05 | V |
| Current Drain Per Pin Excluding VDD and VSS | | 10 | mA |
| Operating Temperature Range | TA | 0 to +70 | °C |
| Storage Temperature Range | T _{stg} | - 55 to + 150 | °C |

THERMAL CHARACTERISTICS

| Characteristics | Symbol | Value | Unit |
|--|-------------|------------------------|------|
| Thermal Resistance Plastic Cerdip Ceramic Chip-Carrier | θ JA | 100 60 50 TBD | °C/W |

This device contains circuitry to protect the inputs against damage due to high static voltages or electric fields; however, it is advised that normal precautions be taken to avoid application of any voltage higher than maximum rated voltages to this high impedance circuit For proper operation it is recommended that V_{ID} and V_{Out} be constrained to the range $V_{SS} \le (V_{ID}) = V_{OUT} = V_{OUT}$. Reliability of operation is enhanced if unused inputs are tied to an appropriate logic voltage level (e.g., either V_{SS} or V_{DD})

FIGURE 1 - MICROPROCESSOR BLOCK DIAGRAM



DC ELECTRICAL CHARACTERISTICS 3.0 V (V_{DD} = 3 0 Vdc, V_{SS} = 0, T_A = 0° to 70°C, unless otherwise noted)

| Characteristics | Symbol | Min | Max | Unit |
|--|--------------------|---------------------|------------------|------|
| Output Voltage I _I ΩΔD≤10 0 μA | VOL | - | 0 1 | V |
| | Voн | V _{DD} -01 | | |
| Total Supply Current ($C_L = 50 \text{ pF} - \text{no DC loads}$) $t_{CYC} = 5 \mu \text{s}$ | | 1 | | |
| Run $(V_{IL} = 0.2 \text{ V}, V_{IH} = V_{DD} - 0.2 \text{ V})$ | IDD | _ | 13 | mA |
| Wait (Test Conditions — See Note Below) | loo | _ | 200 | μΑ |
| Stop (Test Conditions — See Note Below) | IDD | | 100 | μΑ |
| Output High Voltage | | | | |
| (I _{LOAD} = 0 25 mA) A8-A12,B0-B7 | _V _{OH} _ | 27 | _ | V |
| (I _{LOAD} = 0 1 mA) PA0-PA7, PB0-PB7 | Voн | 2 7 | | V |
| $(I_{LOAD} = 0.25 \text{ mA}) DS, AS, R/\overline{W}$ | Voн | 2 7 | _ | ٧ |
| Output Low Voltage | | | | |
| (I _{LOAD} = 0 25 mA) A8-A12, B0-B7 | VOL | - | 03 | V |
| (I _{LOAD} =0 25 mA) PA0-PA7, PB0-PB7 | VOL | _ | 03 | V |
| $(I_{LOAD} = 0.25 \text{ mA}) DS, AS, R/\overline{W}$ | VOL | | 03 | V |
| Input High Voltage | | | | |
| PA0-PA7, PB0-PB7, B0-B7 | ViH | 2 1 | _ | V |
| TIMER, IRO, RESET | ViH | 25 | | V |
| OSC1 | VIH | 2 1 | _ | V |
| Input Low Voltage (All inputs) | VIL | - | 05 | ٧ |
| Frequency of Operation | | | | |
| Crystal | fosc | 0 032 | 1.0 ⁻ | MHz |
| External Clock | fosc | DC | 10 | MHz |
| Input Current | | | | |
| RESET, IRQ, Timer, OSC1 | l _{in} | _ | ±1 | μΑ |
| Three-State Output Leakage | | | | |
| PA0-OA7, PB0-PB7, B0-B7 | ITSL | | ± 10 | μΑ |
| Capacitance | | | | _ |
| RESET, IRQ, Timer | C _{in} | _ | 80 | pF |
| Capacitance | | | 40.0 | |
| DS, AS, R/W, A8-A12, PA0-PA7, PB0-PB7, B0-B7 | C _{out} | | 12 0 | pF |

NOTE Test conditions for Quiescent Current Values are

Port A and B programmed as inputs

 $V_{IL} = 0.2 \text{ V for PA0-PA7, PB0-PB7, and B0-B7}$

VIH = VDD - 0 2 V for RESET, IRQ, and Timer

OSC1 input is a squarewave from V_{SS}+0.2 V to V_{DD} - 0 2 V OSC2 output load (including tester) is 35 pF maximum

Wait mode IDD is affected linearly by this capacitance.

DC ELECTRICAL CHARACTERISTICS 5.0 V (V_{DD} =5 0 Vdc \pm 10%, V_{SS} =0, T_{A} = $\frac{0}{2}$ ° to 70°, unless otherwise noted)

| Characteristics | Symbol | Min | Max | Unit |
|---|------------------|---------------------|------|------|
| Output Voltage I _{1 OAD} ≤10 0 μA | VOL | | 0 1 | V |
| Safett tollage (FOMD = 10.0 M) | Voн | V _{DD} -01 | - | V |
| Total Supply Current ($C_L = 130 \text{ pF} - \text{On Bus}$, $C_L = 50 \text{ pF} - \text{On Ports}$, | | | | |
| No DC Loads, $t_{CYC} = 1.0 \mu s$ | IDD | _ | 10 | mA |
| Run $(V_{IL} = 0.2 \text{ V}, V_{IH} = V_{DD} - 0.2 \text{ V})$ | | | | |
| Wait (Test Conditions — See Note Below) | l DD | | 15 | mA |
| Stop (Test Conditions - See Note Below) | IDD | | 200 | μΑ |
| Output High Voltage | | | | |
| (I _{LOAD} = 1 6 mA) A8-A12, B0-B7 | Voн | 41 | _ | V |
| (I _{LOAD} = 0 36 mA) PA0-PA7, PB0-PB7 | Voн | 41 | - | V |
| $(I_{LOAD} = 1.6 \text{ mA}) DS, AS, R/\overline{W}$ | VOH | 4 1 | _ | V |
| Output Low Voltage | | | | |
| $(I_{LOAD} = 1.6 \text{ mA}) \text{ A8-A12, B0-B7}$ | VOL | _ | 0 4 | l v |
| (I _{LOAD} = 1 6 mA) PA0-PA7, PB0-PB7 | VOL | _ | 0 4 | V |
| $(I_{LOAD} = 1.6 \text{ mA}) DS, AS, R/\overline{W}$ | VOL | _ | 0 4 | V |
| Input High Voltage | | | | |
| PA0-PA7, PB0-PB7 | VIH | VDD-20 | _ | V |
| TIMER, IRQ, RESET | VIH | V _{DD} -08 | _ | V |
| OSC1 | VIH | V _{DD} -15 | | V |
| Input Low Voltage (All Inputs) | V _{IL} | - | 0.8 | V |
| Frequency of Operation | | | | |
| Crystal | fosc | 0 032 | 5 0 | MHz |
| External Clock | fosc | DC | 5 0 | MHz |
| Input Current | | | | |
| RESET, IRQ, Timer, OSC1 | l _{in} | _ | ±1 | μΑ |
| Three-State Output Leakage | | | | İ |
| PAO-PA7, PBO-PB7, BO-B7 | lTSI | _ | ± 10 | μΑ |
| Capacitance | | | | |
| RESET, IRQ, Timer | C _{in} | | 8 0 | pF |
| Capacitance | | | | 1 |
| DS, AS, R/W, A8-A12, PA0-PA7, PB0-PB7, B0-B7 | C _{out} | | 12 0 | pF |

NOTE Test conditions for Quiescent Current Values are

Port A and B programmed as inputs

VIL = 0 2 V for PA0-PA7, PB0-PB7, and B0-B7

VIH = VDD - 0 2 V for RESET, IRQ, and Timer

OSC1 input is a squarewave from VSS+0 2 V to VDD - 0 2 V

OSC2 output load (including tester) is 35 pF maximum

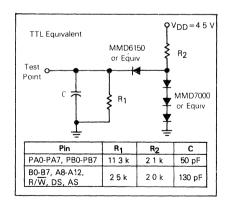
Wait mode (IDD) is affected linearly by this capacitance

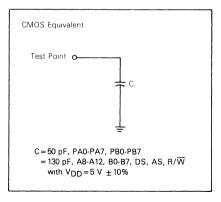
TABLE 1 — CONTROL TIMING (VSS=0, TA=0° to 70°C)

| | | V_{DD} = 3.0 V V_{DD} = 5.0 V \pm 10% f_{OSC} = 5.0 MHz | | | | | | |
|--|----------|---|-----|-----|------|-----|-----|------------------|
| Characteristics | Symbol | Min | Тур | Max | Min | Тур | Max | Unit |
| I/O Port Timing — Input Setup Time (Figure 3) | †PVASL | 500 | _ | _ | 250 | Ī - | _ | ns |
| Input Hold Time (Figure 3) | †ASLPX | 100 | - | _ | 100 | _ | _ | ns |
| Output Delay Time (Figure 3) | †ASLPV | _ | _ | 0 | _ | _ | 0 | ns |
| Interrupt Setup Time (Figure 6) | ILASL | 2 | _ | | 04 | _ | _ | μS |
| Crystal Oscillator Startup Time (Figure 5) | toxov | _ | 30 | 300 | _ | 15 | 100 | ms |
| Wait Recovery Startup Time (Figure 7) | tIVASH | _ | _ | 10 | _ | | 2 | μS |
| Stop Recovery Startup Time (Crystal Oscillator) (Figure 8) | tILASH | - | 30 | 300 | _ | 15 | 100 | ms |
| Required Interrupt Release (Figure 6) | †DSLIH | | _ | 5 | _ | | 10 | μS |
| Timer Pulse Width (Figure 7) | tTH, tTL | 05 | - | _ | 0.5 | | _ | tcyc |
| Reset Pulse Width (Figure 5) | tRL | 52 | | _ | 1 05 | | | μS |
| Timer Period (Figure 7) | †TLTL | 10 | _ | _ | 10 | _ | _ | t _{cyc} |
| Interrupt Pulse Width Low (Figure 16) | tILIH | 10 | - | | 10 | T - | _ | tcvc |
| Interrupt Pulse Period (Figure 16) | tilil | * | | | * | T- | - | tcvc |
| Oscillator Cycle Period (1/5 of t _{Cyc}) | tOLOL | 1000 | | | 200 | T | - | ms |
| OSC1 Pulse Width High | tOH | 350 | _ | | 75 | _ | _ | ns |
| OSC1 Pulse Width Low | tOL | 350 | - | _ | 75 | _ | _ | ns |
| | | | | | | | | |

^{*}The minimum period t_{ILIL} should not be less than the number of t_{CVC} cycles it takes to execute the interrupt service routine plus 20 t_{CVC} cycles

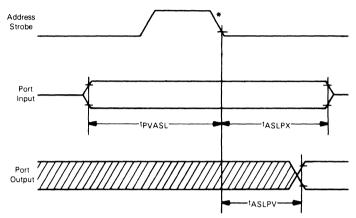
FIGURE 2 - EQUIVALENT TEST LOADS





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FIGURE 3 - I/O PORT TIMING (V_{LOW} = 0 8 V, V_{HIGH} = V_{DD} -2 0 V, V_{DD} = 5 0 \pm 10%. Temp=0° to 70°C, C_L on Port=50 pF, f_{OSC}=5 MHz)

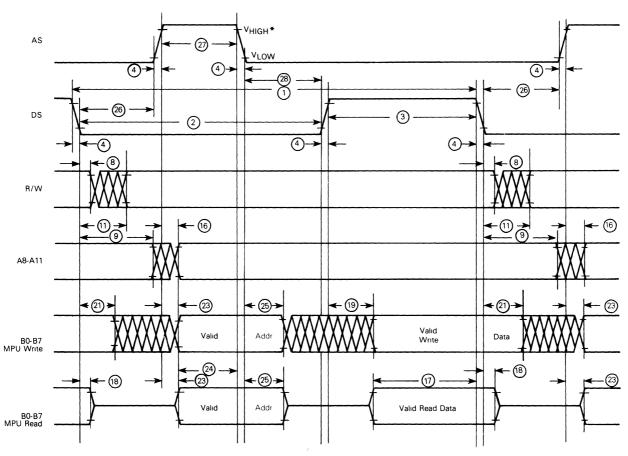


 $^{{}^{\}hbox{\scriptsize #}}{}$ The address strobe of the first cycle of the next instruction as shown in Table 11

TABLE 2 — BUS TIMING ($T_A = 0^{\circ}$ to 70°C, $V_{SS} = 0$ V) See Figure 4

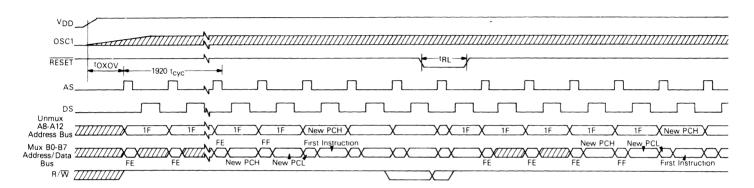
| Num | Characteristics | Symbol | V _{DD} = | | | V _{DD} =5.0 V ± 10%, 1 TTL | |
|-----|--------------------------------------|---------------------------------|-------------------|------|------|--|----|
| | | | Min | Max | Min | Max | |
| 1 | Cycle Time | tcyc | 5000 | DC | 1000 | DC | ns |
| 2 | Pulse Width, DS Low | PWEL | 2800 | _ | 560 | | ns |
| 3 | Pulse Width, DS High or RD, WR, Low | PWEH | 1800 | _ | 375 | _ | ns |
| 4 | Clock Transition | t _r , t _f | | 100 | _ | 30 | ns |
| 8 | R/W Hold | tRWH | 10 | _ | 10 | _ | ns |
| 9 | Non-Muxed Address Hold | tAH | 800 | _ | 100 | _ | ns |
| 11 | R/W Delay from DS Fall | tAD | - | 500 | _ | 300 | ns |
| 16 | Non-Muxed Address Delay from AS Rise | tADH | 0 | 200 | 0 | 100 | ns |
| 17 | MPU Read Data Setup | tDSR | 200 | | 115 | _ | ns |
| 18 | Read Data Hold | tDHR | 0 | 1000 | 0 | 160 | ns |
| 19 | MPU Data Delay, Write | tDDW | | 0 | - | 120 | ns |
| 21 | Write Data Hold | tDHW | 800 | _ | 55 | _ | ns |
| 23 | Muxed Address Delay from AS Rise | tBHD | 0 | 250 | 0 | 120 | ns |
| 24 | Muxed Address Valid to AS Fall | tASL | 600 | _ | 55 | _ | ns |
| 25 | Muxed Address Hold | tAHL | 250 | 750 | 60 | 180 | ns |
| 26 | Delay DS Fall to AS Rise | tASD | 800 | _ | 160 | _ | ns |
| 27 | Pulse Width, AS High | PWASH | 850 | | 175 | | ns |
| 28 | Delay, AS Fall to DS Rise | tASED | 800 | _ | 160 | _ | ns |

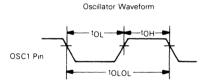
FIGURE 4 - MC146805E2 BUS TIMING

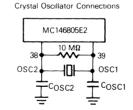


^{*} V_{HIGH} = 2 0 V, V_{LOW} = 0 5 V for V_{DD} = 3 V V_{HIGH} = V_{DD} - 2 0 V, V_{LOW} = 0 8 V for V_{DD} = 5 V \pm 10%

FIGURE 5 - POWER-ON RESET AND RESET TIMING







Crystal Parameters Representative Frequencies

| | 5.0 MHz | 4.0 MHz | 1.0 MHz |
|-------------------|----------|----------|----------|
| RS max | 50Ω | 75Ω | 400Ω |
| C0 | 8 pF | 7 pF | 5 pF |
| C1 | 0 02 pF | 0 012 pF | 0 008 pF |
| Q | 50 k | 40 k | 30 k |
| Cosc ₁ | 15-30 pF | 15-30 pF | 15-40 pF |
| COSC2 | 15-25 pF | 15-25 pF | 15-30 pF |

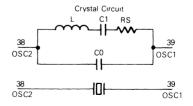
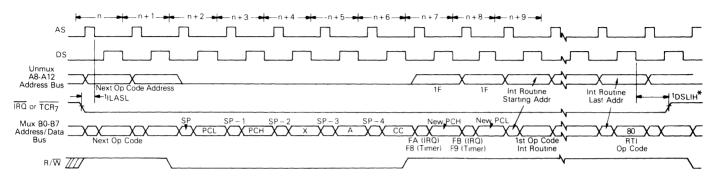


FIGURE 6 - IRQ AND TCR7 INTERRUPT TIMING



*tpSLIH - The interrupting device must release the IRQ line within this time to prevent subsequent recognition of the same interrupt

FIGURE 7 - TIMER INTERRUPT AFTER WAIT INSTRUCTION: TIMING

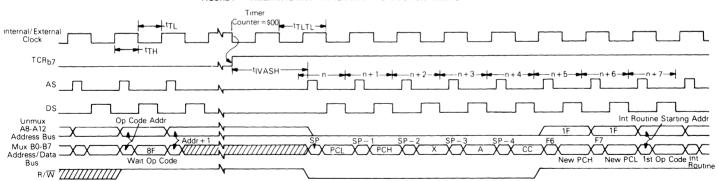
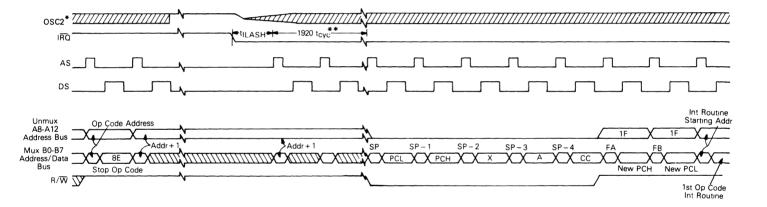


FIGURE 8 - INTERRUPT RECOVERY FROM STOP INSTRUCTION: TIMING



^{*}Represents the internal gating of the OSC1 input pin toyc is one instruction cycle (for fOSC=5 MHz, toyc=1 μ s)

FUNCTIONAL PIN DESCRIPTION

 V_{DD} and V_{SS} - V_{DD} and V_{SS} provide power to the chip V_{DD} provides power and V_{SS} is ground

 $\overline{\text{IRO}}$ (Maskable Interrupt Request) — $\overline{\text{IRO}}$ is a level-sensitive and edge sensitive input which can be used to request an interrupt sequence. The MPU completes the current instruction before it responds to the request. IF $\overline{\text{IRO}}$ is low and the interrupt mask bit (I-bit) in the Condition Code Register is clear, the MPU begins an interrupt sequence at the end of the current instruction. The interrupt circuit recognizes both a "Wire ORed" level as well as pulses on the IRO line (see Interrupt Section for more details). IRO requires an external resistor to VDD for "Wire OR" operation

RESET — The RESET input is not required for start-up but can be used to reset the MPU's internal state and provide an orderly software start-up procedure. Refer to the RESET section for a detailed description.

TIMER — The TIMER input is used for clocking the onchip timer. Refer to TIMER section for a detailed description

AS (Address Strobe) — Address Strobe (AS) is an output strobe used to indicate the presence of an address on the 8-bit multiplexed bus. The AS line is used to demultiplex the eight least significant address bits from the data bus. A latch controlled by Address Strobe should capture addresses on the negative edge. This output is capable of driving one standard TTL load and 130 pF and is available at fQSC — 5 when the MPU is not in the WAIT or STOP states.

DS (Data Strobe) — This output is used to transfer data to or from a peripheral or memory. DS occurs anytime the MPU does a data read or write DS also occurs when the MPU does a data transfer to or from the MPU's internal memory. Refer to Table 2 and Figure 4 for timing characteristics This output is capable of driving one standard TTL load and

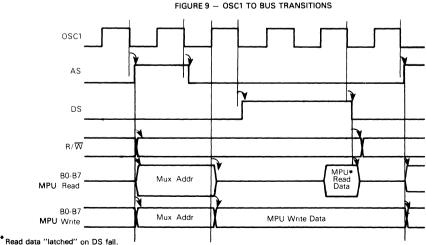
130 pF DS is a continuous signal at fOSC +5 when the MPU is not in WAIT or STOP state. Some bus cycles are redundant reads of op code bytes.

 R/\overline{W} (Read/Write) — The R/\overline{W} output is used to indicate the direction of data transfer for both internal memory and I/O registers, and external peripheral devices and memories. This output is used to indicate to a selected peripheral whether the MPU is going to read or write data on the next Data Strobe (R/\overline{W} low = processor write, R/\overline{W} high = processor read). The R/\overline{W} output is capable of driving one standard TTL load and 130 pF. The normal standby state is Read (high).

A8-A12 (High Order Address Lines) — The A8-A12 output lines constitute the higher order non-multiplexed addresses. Each output line is capable of driving one standard TTL load and 130 pF.

B0-B7 (Address/Data Bus) — The B0-B7 bidirectional lines constitute the lower order addresses and data These lines are multiplexed, with address present at Address Strobe time and data present at Data Strobe time. When in the data mode, these lines are bidirectional, transferring data to and from memory and peripheral devices as indicated by the R/\overline{W} pin. As outputs in either the data or address modes, these lines are capable of driving one standard TTL load and 130 pF

OSC1, OSC2 — The MC146805E2 provides for two types of oscillator inputs — crystal circuit or external clock. The two oscillator pins are used to interface to a crystal circuit, as shown in Figure 5. If an external clock is used, it must be connected to OSC1. The input at these pins is divided by five to form the cycle rate seen on the AS and DS pins. The frequency range is specified by fOSC. The OSC1 to bus transitions relationships are provided in Figure 9 for system designs using oscillators slower than 5 MHz.

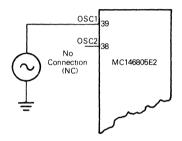


nead data lateried on DS fall.

Crystal — The circuit shown in Figure 5 is recommended when using a crystal. The internal oscillator is designed to interface with an AT-cut parallel resonant quartz crystal resonator in the frequency range specified for f_{OSC} in the electrical characteristics table. An external CMOS oscillator is recommended when crystals outside the specified ranges are to be used. The crystal and components should be mounted as close as possible to the input pins to minimize output distortion and start-up stabilization time.

External Clock — An external clock should be applied to the OSC1 input with the OSC2 input not connected, as shown in Figure 10

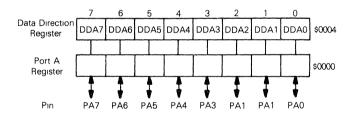
FIGURE 10 - EXTERNAL CLOCK CONNECTION

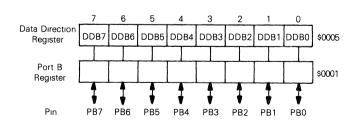


LI (Load Instruction) — This output is used to indicate that a fetch of the next opcode is in progress. LI remains low during an External or Timer interrupt. The LI output is only used for certain debugging and test systems. For normal operations this pin is not connected. The LI output is capable of driving one standard. TTL load and 50 pF. This signal overlaps. Data Strobe.

PA0-PA7 - These eight pins constitute Input/Output Port A. Each line is individually programmed to be either an input or output under software control via its Data Direction Register as shown below An I/O pin is programmed as an output when the corresponding DDR bit is set to a "1," and as an input when it is set to a "0" In the output mode the bits are latched and appear on the corresponding output pins. An MPU read of the port bits programmed as outputs reflect the last value written to that location. When programmed as an input, the input data bit(s) are not latched. An MPU read of the port bits programmed as inputs reflects the current status of the corresponding input pins. The Read/Write port timing is shown in Figure 3 See typical I/O Port Circuitry in Figure 11 During a Power-On Reset or external RESET all lines are configured as inputs (zero in Data Direction Register) The output port register is not initialized by reset. The TTL compatible three-state output buffers are capable of driving one standard TTL load and 50 pF. The DDR is a read/write register

PB0-PB7 — These eight pins interface to Input/Output Port B Refer to PA0-PA7 description for details of operation





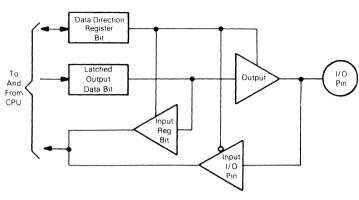


FIGURE 11 - TYPICAL PORT I/O CIRCUITRY

TABLE 3 - I/O PIN FUNCTIONS

| R/W | DDR | 1/O Pin Functions |
|-----|-----|---|
| 0 | 0 | The I/O pin is in input mode. Data is written into the output data latch. |
| 0 | 1 | Data is written into the output data latch and output to the I/O pin |
| 1 | 0 | The state of the I/O pin is read |
| 1 | 1 | The I/O pin is in an output mode. The output data latch is read. |

MEMORY ADDRESSING

The MC146805E2 is capable of addressing 8192 bytes of memory and I/O registers. The address space is divided into internal memory space and external memory space, as shown in Figure 12.

The internal memory space is located within the first 128 bytes of memory (first half of page zero) and is comprised of the I/O port locations, timer locations, and 112 bytes of RAM. The MPU can read from or write to any of these locations. A program write to on-chip locations is repeated on the external bus to permit off-chip memory to duplicate the content of on-chip memory. Program reads to on-chip locations also appear on the external bus, but the MPU accepts data only from the addressed on-chip location. Any read data appearing on the input bus is ignored.

The stack pointer is used to address data stored on the stack Data is stored on the stack during interrupts and subroutine calls. At power up, the stack pointer is set to \$7F and it is decremented as data is pushed onto the stack. When data is removed from the stack, the stack pointer is incremented. A maximum of 64 bytes of RAM is available for stack usage. Since most programs use only a small part of the allotted stack locations for interrupts and/or subroutine stacking purposes, the unused bytes are usable for program data storage.

All memory locations above location \$007F are part of the external memory map. In addition, ten locations in the I/O portion of the lower 128 bytes of memory space, as shown

in Figure 12, are part of the external memory map. All of the external memory space is user definable except the highest 10 locations. Locations \$1FF6 to \$1FFF of the external address space are reserved for interrupt and reset vectors (see Figure 12).

REGISTERS

The MC146805E2 contains five registers as shown in the programming model in Figure 13. The interrupt stacking order is shown in Figure 14.

ACCUMULATOR (A) — This Accumulator is an 8-bit general purpose register used for arithmetic calculations and data manipulations

INDEX REGISTER (X) — The X register is an 8-bit register which is used during the indexed modes of addressing. It provides an 8-bit operand which is used to create an effective address. The index register is also used for data manipulations with the Read/Modify/Write type of instructions and as a temporary storage register when not performing addressing operations.

PROGRAM COUNTER (PC) — The program counter is a 13-bit register that contains the address of the next instruction to be executed by the processor

FIGURE 12 - ADDRESS MAP

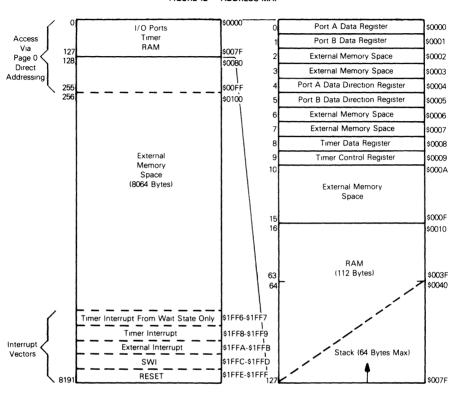


FIGURE 13 - PROGRAMMING MODEL

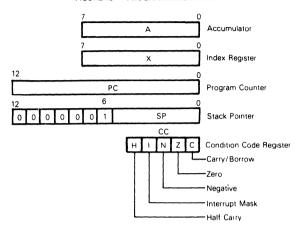
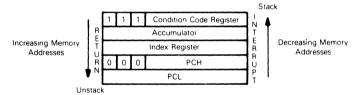


FIGURE 14 - STACKING ORDER



NOTE Since the Stack Pointer decrements during pushes, the PCL is stacked first, followed by PCH, etc. Pulling from the stack is in the reverse order.

STACK POINTER (SP) — The stack pointer is a 13-bit register containing the address of the next free location on the stack. When accessing memory, the seven most-significant bits are permanently set to 0000001. They are appended to the six least-significant register bits to produce an address within the range of \$007F to \$0040. The stack area of RAM is used to store the return address on subroutine calls and the machine state during interrupts. During external or power-on reset, and during a "reset stack pointer" instruction, the stack pointer is set to its upper limit (\$007F). Nested interrupts and/or subroutines may use up to 64 (decimal) locations, beyond which the stack pointer "wraps around" and points to its upper limit thereby losing the previously stored information. A subroutine call occupies two RAM bytes on the stack, while an interrupt uses five bytes.

CONDITION CODE REGISTER (CC) — The condition code register is a 5-bit register in which each bit is used to indicate the results of the instruction just executed. These bits can be individually tested by a program and specific action

taken as a result of their state. Each of the five bits is explained below

Half Carry Bit (H) — The H-bit is set to a one when a carry occurs between bits 3 and 4 of the ALU during an ADD or ADC instruction. The H-bit is useful in Binary Coded Decimal addition subroutines.

Interrupt Mask Bit (I) — When the I-bit is set, both the external interrupt and the timer interrupt are disabled. Clearing this bit enables the above interrupts. If an interrupt occurs while the I-bit is set, the interrupt is latched and will be processed when the I-bit is next cleared.

Negative Bit (N) — When set, this bit indicates that the result of the last arithmetic, logical, or data manipulation was negative (bit 7 in the result is a logical one).

Zero Bit (Z) — When set, this bit indicates that the result of the last arithmetic, logical, or data manipulation was zero.

Carry Bit (C) - The C-bit is set when a carry or a borrow out of the ALU occurs during an arithmetic instruction. The C-bit is also modified during bit test, shift, rotate, and branch types of instruction

RESETS

The MC146805E2 has two reset modes an active low external reset pin (RESET) and a Power-On Reset function, refer to Figure 5

RESET (Pin #1) - The RESET input pin is used to reset the MPU and provide an orderly software start-up procedure When using the external reset mode, the RESET pin must stay low for a minimum of one $t_{\mbox{\scriptsize CVC}}$ The $\overline{\mbox{\scriptsize RESET}}$ pin is provided with a Schmitt Trigger to improve its noise immunity capability

Power-On Reset - The Power-on Reset occurs when a positive transition is detected on VDD. The Power-on Reset is used strictly for power turn-on conditions and should not be used to detect any drops in the power supply voltage There is no provision for a power-down reset. The power-oncircuitry provides for a 1920 t_{CyC} delay from the time of the first oscillator operation. If the external reset pin is low at the end of the 1920 t_{CYC} time out, the processor remains in the reset condition

Either of the two types of reset conditions causes the following to occur

- Timer control register interrupt request bit (bit 7) is cleared to a "0"
- Timer control register interrupt mask bit (bit 6) is set to a "1"
- All data direction register bits are cleared to a "0" (inputs)
- Stack pointer is set to \$007F
- The address bus is forced to the reset vector (\$1FFE, \$1FFF)
- Condition code register interrupt mask bit (I) is set to a "1"
- STOP and WAIT latches are reset
- External interrupt latch is reset

All other functions, such as other registers (including output ports) the timer, etc., are not cleared by the reset conditions

INTERRUPTS

The MC146805E2 is capable of operation with three different interrupts, two hardware (timer interrupt and external interrupt) and one software (SWI). When any of these interrupts occur, normal processing is suspended at the end of the current instruction execution. All of the program registers (the machine state) are pushed onto the stack, refer to Figure 14 for stacking order. The appropriate vector pointing to the starting address of the interrupt service routine is then fetched, refer to Figure 15 for the interrupt sequence

The priority of the various interrupts from highest to lowest is as follows

RESET→ *→ External Interrupt → Timer Interrupt

cleared, then each time the timer decrements to zero (transitions from \$01 to \$00) an interrupt request is generated. The actual processor interrupt is generated only if the interrupt

TIMER INTERRUPT - If the timer mask bit (TCR6) is

mask bit of the condition code register is also cleared. When the interrupt is recognized, the current state of the machine is pushed onto the stack and the l-bit in the condition code register is set. This masks further interrupts until the present one is serviced. The processor now vectors to the timer interrupt service routine. The address for this service routine is specified by the contents of \$1FF8 and \$1FF9 unless the processor is in a WAIT mode in which case users of mask versions BP4XXXX and AW9XXXX should refer to the appendix for additional information regarding exceptions to this function The contents of \$1FF6 and \$1FF7 specify the service routine. Also, software must be used to clear the timer interrupt request bit (TCR7) At the end of the timer interrupt service routine, the software normally executes an RTI instruction which restores the machine state and starts executing the interrupted program.

EXTERNAL INTERRUPT - If the interrupt mask bit of the condition code register is cleared and the external interrupt pin IRQ is "low," then the external interrupt occurs. The action of the external interrupt is identical to the timer interrupt with the exception that the service routine address is specified by the contents of \$1FFA and \$1FFB. The interrupt logic recognizes both a "wire ORed" level and pulses on the external interrupt line Figure 16 shows both a functional diagram and timing for the interrupt line. The timing diagram shows two different treatments of the interrupt line (IRQ) to the processor. The first configuration shows many interrupt lines "wire ORed" to form the interrupts at the processor Thus, if after servicing an interrupt the IRQ remains low, then the next interrupt is recognized. The second method is single pulses on the interrupt line spaced far enough apart to be serviced Users of mask versions BP4XXXX and AW9XXXX should refer to the appendix regarding exceptions to this function. The minimum time between pulses is a function of the length of the interrupt service routine. Once a pulse occurs, the next pulse should not occur until the MPU software has exited the routine (an RTI occurs) This time (tij ji) is obtained by adding 20 instruction cycles (one cycle t_{CVC} = 5/f_{OSC}) to the total number of cycles it takes to complete the service routine including the RTI instruction, refer to Figure 6.

SOFTWARE INTERRUPT (SWI) - The software interrupt is an executable instruction. The action of the SWI instruction is similar to the hardware interrupts. The SWI is executed regardless of the state of the interrupt mask in the condition code register. The service routine address is specified by the contents of memory locations \$1FFC and \$1FFD See Figure 15 for Interrupt and Instruction Processing Flowchart

The following three functions are not strictly interrupts, however, they are tied very closely to the interrupts. These functions are RESET, STOP, WAIT

RESET — The RESET input pin and the internal Power-on Reset function each cause the program to vector to an initialization program. This vector is specified by the contents of memory locations \$1FFE and \$1FFF. The interrupt mask of the condition code register is also set Refer to RESET section for details

^{*}Any current instruction including SWI

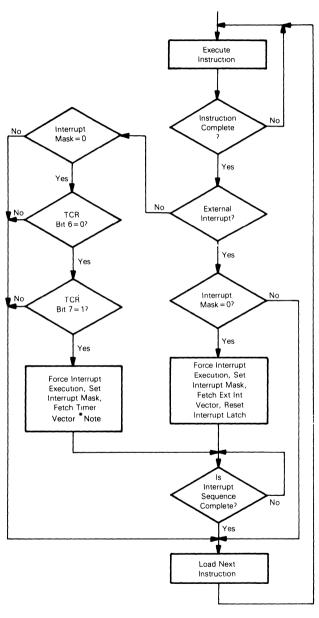
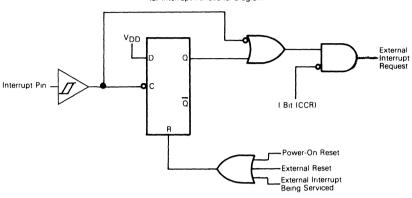


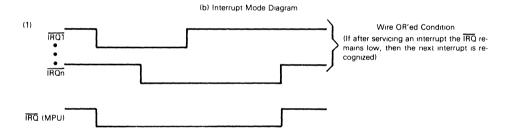
FIGURE 15 - INTERRUPT AND INSTRUCTION PROCESSING FLOWCHART

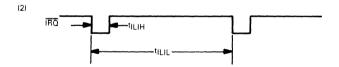
^{*}NOTE The clear of TCR bit 7 must be accomplished with software

FIGURE 16 - EXTERNAL INTERRUPT

(a) Interrupt Functional Diagram







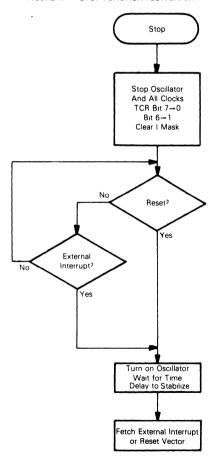
Pulse Condition

The minimum pulse width (t_{ILIH}) is one t_{CVC} . The period t_{ILIL} should not be less than the number of t_{CVC} cycles it takes to execute the interrupt service routine plus 20 t_{CVC} cycles

STOP — The STOP instruction places the MC146805E2 in a low power consumption mode. In the STOP function the internal oscillator is turned off, causing all internal processing and the timer to be halted, refer to Figure 17. The DS and AS lines go to a low state and the R/W line goes to a high state. The multiplexed address/data bus goes to the data input state. The high order address lines remain at the address of the next instruction. The MPU remains in the STOP mode until an external interrupt or reset occurs, refer to Figure 8 and 17.

During the STOP mode, timer control register (TCR) bits 6 and 7 are altered to remove any pending timer interrupt requests and to disable any further timer interrupts. External interrupts are enabled in the condition code register. All other registers and memory remain unaltered. All I/O lines remain unchanged.

FIGURE 17 - STOP FUNCTION FLOWCHART



WAIT — The WAIT instruction places the MC146805E2 in a low power consumption mode, but the WAIT mode con-

sumes somewhat more power than the STOP mode, refer to Table 1. In the WAIT function, the internal clock is disabled from all internal circuitry except the Timer circuit, refer to Figure 18. Thus, all internal processing is halted except the Timer which is allowed to count in a normal sequence. The R/\overline{W} line goes to a high state, the multiplexed address/data bus goes to the data input state, and the DS and AS lines go to the low state. The high order address lines remain at the address of the next instruction. The MPU remains in this state until an external interrupt, timer interrupt, or a reset occurs, refer to Figures 7 and 18.

During the WAIT mode, the I-bit in the condition code register is cleared to enable interrupts. All other registers, memory, and I/O lines remain in their last state. The timer may be enabled to allow a periodic exit from the WAIT mode. If an external and a timer interrupt occur at the same time, the external interrupt is serviced first, then, if the timer interrupt request is not cleared in the external interrupt routine, the normal timer interrupt (not the timer WAIT interrupt) is serviced since the MCU is no longer in the WAIT mode.

TIMER

The MPU timer contains a single 8-bit software programmable counter with 7-bit software selectable prescaler. The counter may be preset under program control and decrements towards zero. When the counter decrements to zero, the timer interrupt request bit, i.e., bit 7 of the Timer Control Register (TCR) is set. Then if the timer interrupt is not masked, i.e., bit 6 of the TCR and the l-bit in the Condition Code Register are both cleared, the processor receives an interrupt. After completion of the current instruction, the processor proceeds to store the appropriate registers on the stack, and then fetches the timer vector address from locations \$1FF8 and \$1FF9 in order to begin servicing the interrupt, unless it was in locations \$1FF6 and \$1FF7 the WAIT mode

The counter continues to count after it reaches zero, allowing the software to determine the number of internal or external input clocks since the timer interrupt request bit was set. The counter may be read at any time by the processor without disturbing the count. The contents of the counter becomes stable prior to the read portion of a cycle and does not change during the read. The timer interrupt request bit remains set until cleared by the software. If this happens before the timer interrupt is serviced, the interrupt is lost TCR7 may also be used as a scanned status bit in a non-interrupt mode of operation (TCR6=1).

The prescaler is a 7-bit divider which is used to extend the maximum length of the timer. Bit 0, bit 1, and bit 2 of the TCR are programmed to choose the appropriate prescaler output which is used as the counter input. The processor cannot write into or read from the prescaler, however, its contents are cleared to all "0's" by the write operation into TCR when bit 3 of the written data equals 1, which allows for truncation-free counting

The Timer input can be configured for three different operating modes, plus a disable mode depending on the value written to the TCR4, TCR5 control bits Refer to the TIMER CONTROL REGISTER section.

Timer Input Mode 1 - If TCR4 and TCR5 are both programmed to a "0", the input to the Timer is from an internal clock and the Timer input is disabled. The internal clock mode can be used for periodic interrupt generation, as well

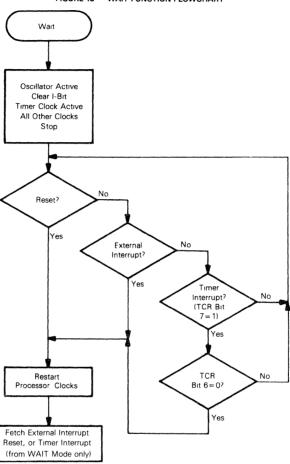


FIGURE 18 - WAIT FUNCTION FLOWCHART

as a reference in frequency and event measurement. The internal clock is the instruction cycle clock and is coincident with Address Strobe (AS) except during a WAIT instruction. During a WAIT instruction the AS pin goes to a low state but the internal clock to the Timer continues to run at its normal rate.

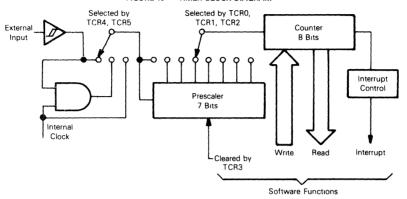
Timer Input Mode 2 — With TCR4=1 and TCR5=0, the internal clock and the TIMER input pin are ANDed together to form the Timer input signal. This mode can be used to measure external pulse widths. The external pulse simply turns on the internal clock for the duration of the pulse. The resolution of the count in this mode is ± 1 clock and therefore accuracy improves with longer input pulse widths.

Timer Input Mode 3 - If TCR4=0 and TCR5=1, then all inputs to the Timer are disabled

Timer Input Mode 4 — If TCR4=1 and TCR5=1, the internal clock input to the Timer is disabled and the TIMER input pin becomes the input to the Timer. The external Timer pin can, in this mode, be used to count external events as well as external frequencies for generating periodic interrupts

Figure 19 shows a block diagram of the Timer subsystem Power-on Reset and the STOP instruction cause the counter to be set to \$FO

FIGURE 19 - TIMER BLOCK DIAGRAM



NOTES

- 1 Prescaler and 8-bit counter are clocked falling edge of the internal clock (AS) or external input.
- 2 Counter is written to during Data Strobe (DS) and counts down continuously

Timer Control Register (TCR)

| 7 | 6 | 5 | 4 | 3 | 2 | • 1 | 0 |
|------|------|------|------|------|------|------|------|
| TCR7 | TCR6 | TCR5 | TCR4 | TCR3 | TCR2 | TCR1 | TCR0 |

All bits in this register except bit 3 are Read/Write bits

 ${\bf TCR7}-{\bf Timer}$ interrupt request bit bit used to indicate the timer interrupt when it is logic "1"

- Set whenever the counter decrements to zero, or under program control
- Cleared on external reset, power-on reset, STOP instruction, or program control

 ${\sf TCR6}-{\sf Timer}$ interrupt mask bit when this bit is a logic "1" it inhibits the timer interrupt to the processor

- Set on external reset, power-on reset, STOP instruction, or program control
- 0 Cleared under program control

TCR5 – External or internal bit selects the input clock source to be either the external timer pin or the internal clock. (Unaffected by $\overline{\text{RESET}}$)

- 1 Select external clock source.
- 0 Select internal clock source (AS).

TCR4 — External enable bit control bit used to enable the external timer pin. (Unaffected by RESET)

- 1 Enable external timer pin
- 0 Disable external timer pin

TCR5 TCR4

| - | 0 | 0 | Internal clock (AS) to Timer |
|---|---|---|--------------------------------------|
| | 0 | 1 | AND of internal clock (AS) and TIMER |
| | | | pin to Timer |
| | 1 | 0 | Inputs to Timer disabled |
| | 1 | 1 | TIMER pin to Timer |

Refer to Figure 19 for Logic Representation

TCR3 — Timer Prescaler Reset bit writing a "1" to this bit resets the prescaler to zero. A read of this location always indicates a "0" (Unaffected by $\overline{\text{RESET}}$)

TCR2, TCR1, TCR0 — Prescaler address bits, decoded to select one of eight taps on the prescaler (Unaffected by $\overline{\text{RESET}}$)

Prescaler

| | Pres | scaier | |
|------|------|--------|-------------|
| TCR2 | TCR1 | TCR0 | Result |
| 0 | 0 | 0 | -1 |
| 0 | 0 | 1 | -2 |
| 0 | 1 | 0 | -4 |
| 0 | 1 | 1 | -8 |
| 1 | 0 | 0 | ∸ 16 |
| 1 | 0 | 1 | - 32 |
| 1 | 1 | 0 | - 64 |
| 1 | 1 | 1 | - 128 |

INSTRUCTION SET

The MPU has a set of 61 basic instructions. They can be divided into five different types register/memory, read/modify/write, branch, bit manipulation, and control. The following paragraphs briefly explain each type. All the instructions within a given type are presented in individual tables.

REGISTER/MEMORY INSTRUCTIONS — Most of these instructions use two operands. One operand is either the accumulator or the index register. The other operand is obtained from memory using one of the addressing modes. The jump unconditional (JMP) and jump to subroutine (JSR) instructions have no register operand. Refer to Table 4.

READ/MODIFY/WRITE INSTRUCTIONS — These instructions read a memory location or a register, modify or test its contents, and write the modified value back to memory or to the register. The test for negative or zero (TST) instruction is an exception to the read/modify/write sequence since it does not modify the value. Refer to Table 5.

BRANCH INSTRUCTIONS — This set of instructions branches if a particular condition is met, otherwise no operation is performed. Branch instructions are two byte instructions. Refer to Table 6.

BIT MANIPULATION INSTRUCTIONS — The MPU is capable of setting or clearing any bit which resides in the first 256 bytes of the memory space, where all port registers, port DDRs, timer, timer control, and on-chip RAM reside. An additional feature allows the software to test and branch on the state of any bit within these 256 locations. The bit set, bit clear and bit test and branch functions are all implemented with a single instruction. For the test and branch instructions the value of the bit tested is also placed in the carry bit of the Condition Code Register. Refer to Table 7 for instruction cycle timing.

CONTROL INSTRUCTIONS — These instructions are register reference instructions and are used to control processor operation during program execution. Refer to Table 8 for instruction cycle timing.

 $\begin{tabular}{ll} ALPHABETICAL LISTING - The complete instruction set is given in alphabetical order in Table 9 \end{tabular}$

OPCODE MAP SUMMARY — Table 10 is an opcode map for the instructions used on the MCU

ADDRESSING MODES

The MPU uses ten different addressing modes to give the programmer an opportunity to optimize the code to all situations. The various indexed addressing modes make it possible to locate data tables, code conversion tables and scaling tables anywhere in the memory space Short indexed accesses are single byte instructions, while the longest instructions (three bytes) permit tables throughout memory. Short and long absolute addressing is also included. Two byte

direct addressing instructions access all data bytes in most applications. Extended addressing permits jump instructions to reach all memory. Table 9 shows the addressing modes for each instruction, with the effects each instruction has on the Condition Code Register. An opcode map is shown in Table 10.

The term "Effective Address" or EA is used in describing the various addressing modes, which is defined as the address to or from which the argument for an instruction is fetched or stored. The ten addressing modes of the processor are described below. Parentheses are used to indicate "contents of," an arrow indicates "is replaced by" and a colon indicates concatenation of two bytes.

Inherent — In inherent instructions all the information necessary to execute the instruction is contained in the opcode Operations specifying only the index register or accumulator, and no other arguments, are included in this mode

Immediate — In immediate addressing, the operand is contained in the byte immediately following the opcode. Immediate addressing is used to access constants which do not change during program execution (e.g., a constant used to initialize a loop counter)

$$EA = PC + 1$$
, $PC \leftarrow PC + 2$

Direct — In the direct addressing mode, the effective address of the argument is contained in a single byte following the opcode byte. Direct addressing allows the user to directly address the lowest 256 bytes in memory with a single two byte instruction. This includes all on-chip RAM and I/O registers and up to 128 bytes of off-chip ROM. Direct addressing is efficient in both memory and speed.

$$EA = (PC + 1), PC \leftarrow PC + 2$$

Address Bus High $\leftarrow 0$, Address Bus Low $\leftarrow (PC + 1)$

Extended — In the extended addressing mode, the effective address of the argument is contained in the two bytes following the opcode Instructions with extended addressing modes are capable of referencing arguments anywhere in memory with a single three byte instruction. When using the Motorola assembler, the user need not specify whether an instruction uses direct or extended addressing. The assembler automatically selects the most efficient addressing mode.

$$EA = (PC + 1) (PC + 2), PC \leftarrow PC + 3$$
Address Bus High $\leftarrow (PC + 1)$, Address Bus Low $\leftarrow (PC + 2)$

Indexed, No-Offset — In the indexed, no offset addressing mode, the effective address of the argument is contained in the 8-bit index register. Thus, this addressing mode can access the first 256 memory locations. These instructions are only one byte long. This mode is used to move a pointer through a table or to address a frequently referenced RAM or 1/O location.

$$EA = X$$
, $PC \leftarrow PC + 1$
Address Bus High $\leftarrow 0$, Address Bus Low $\leftarrow X$

TABLE 4 - REGISTER/MEMORY INSTRUCTIONS

| | | | | | | | | | | Addressir | ng Mode | s | | | | | | | |
|---|----------|------------|------------|-------------|------------|------------|-------------|------------|------------|-------------|------------|------------------------|-------------|------------|---------------------------|-------------|------------|----------------------|-------------|
| | | ١ | mmediat | е | | Direct | | Extended | | | (1 | Indexed (No Offset) | | | Indexed (8-Bit Offset) | | | Indexed B-Bit Off | |
| Function | Mnemonic | Op Code | # Bytes | # Cycles | Op Code | # Bytes | # Cycles | Op Code | # Bytes | # Cycles | Op Code | # Bytes | # Cycles | Op Code | # Bytes | # Cycles | Op Code | # Bytes | # Cycles |
| Load A from Memory | LDA | A6 | 2 | 2 | B6 | 2 | 3 | C6 | 3 | 4 | F6 | 1 | 3 | E6 | 2 | 4 | D6 | 3 | 5 |
| Load X from Memory | LDX | AE | 2 | 2 | BE | 2 | 3 | CE | 3 | 4 | FE | 1 | 3 | EE | 2 | 4 | DE | 3 | 5 |
| Store A in Memory | STA | - | - | - | B7 | 2 | 4 | C7 | 3 | 5 | F7 | 1 | 4 | E7 | 2 | 5 | D7 | 3 | 6 |
| Store X in Memory | STX | - | _ | _ | BF | 2 | 4 | CF | 3 | 5 | FF | 1 | 4 | EF | 2 | 5 | DF | 3 | 6 |
| Add Memory to A | ADD | AB | 2 | 2 | BB | 2 | 3 | СВ | 3 | 4 | FB | 1 | 3 | EB | 2 | 4 | DB | 3 | 5 |
| Add Memory and Carry to A | ADC | A9 | 2 | 2 | В9 | 2 | 3 | С9 | 3 | 4 | F9 | 1 | 3 | E9 | 2 | 4 | D9 | 3 | 5 |
| Subtract Memory | SUB | A0 | 2 | 2 | В0 | 2 | 3 | C0 | 3 | 4 | F0 | 1 | 3 | E0 | 2 | 4 | D0 | 3 | 5 |
| Subtract Memory from A with Borrow | SBC | A2 | 2 | 2 | B2 | 2 | 3 | C2 | 3 | 4 | F2 | 1 | 3 | E2 | 2 | 4 | D2 | 3 | 5 |
| AND Memory to A | AND | Α4 | 2 | 2 | B4 | 2 | 3 | C4 | 3 | 4 | F4 | 1 | 3 | E4 | 2 | 4 | D4 | 3 | 5 |
| OR Memory with A | ORA | AA | 2 | 2 | BA | 2 | 3 | CA | 3 | 4 | FA | 1 | 3 | EA | 2 | 4 | DA | 3 | 5 |
| Exclusive OR Memory with A | EOR | A8 | 2 | 2 | B8 | 2 | 3 | C8 | 3 | 4 | F8 | 1 | 3 | E8 | 2 | 4 | D8 | 3 | 5 |
| Arithmetic Compare A with Memory | СМР | A1 | 2 | 2 | B1 | 2 | 3 | C1 | 3 | 4 | F1 | 1 | 3 | E1 | 2 | 4 | D1 | 3 | 5 |
| Arithmetic Compare X with Memory | CPX | A3 | 2 | 2 | В3 | 2 | 3 | С3 | 3 | 4 | F3 | 1 | 3 | E3 | 2 | 4 | D3 | 3 | 5 |
| Bit Test Memory with A (Logical Compare) | BIT | A 5 | 2 | 2 | B5 | 2 | 3 | C5 | 3 | 4 | F5 | 1 | 3 | E5 | 2 | 4 | D5 | 3 | 5 |
| Jump Unconditional | JMP | _ | - | _ | ВС | 2 | 2 | СС | 3 | 3 | FC | 1 | 2 | EC | 2 | 3 | DC | 3 | 4 |
| Jump to Subroutine | JSR | _ | - | _ | BD | 2 | 5 | CD | 3 | 6 | FD | 1 | 5 | ED | 2 | 6 | DD | 3 | 7 |

TABLE 5 - READ/MODIFY/WRITE INSTRUCTIONS

| | | | | DLL 5 - | ILLAD! | WIODII 1 | / VVIIII L | 11451110 | CTIONS | | | | | | | |
|----------------------------|----------|--------------|------------|-------------|------------|------------|-------------|------------|------------|-------------|------------------------|------------|-------------|---------------------------|------------|-------------|
| | | | | | | | | | Addressi | ng Mode | • | | | | | |
| | | Inherent (A) | | | lr | herent (| X) | Direct | | | Indexed (No Offset) | | | Indexed (8-Bit Offset) | | |
| Function | Mnemonic | Op Code | # Bytes | # Cycles | Op Code | # Bytes | # Cycles | Op Code | # Bytes | # Cycles | Op Code | # Bytes | # Cycles | Op Code | # Bytes | # Cycles |
| Increment | INC | 4C | 1 | 3 | 5C | 1 | 3 | 3C | 2 | 5 | 7C | 1 | 5 | 6C | 2 | 6 |
| Decrement | DEC | 4A | 1 | 3 | 5A | 1 | 3 | 3A | 2 | 5 | 7A | 1 | 5 | 6A | 2 | 6 |
| Clear | CLR | 4F | 1 | 3 | 5F | 1 | 3 | 3F | 2 | 5 | 7F | 1 | 5 | 6F | 2 | 6 |
| Complement | COM | 43 | 1 | 3 | 53 | 1 | 3 | 33 | 2 | 5 | 73 | 1 | 5 | 63 | 2 | 6 |
| Negate (2's Complement) | NEG | 40 | 1 | 3 | 50 | 1 | 3 | 30 | 2 | 5 | 70 | 1 | 5 | 60 | 2 | 6 |
| Rotate Left Thru Carry | ROL | 49 | 1 | 3 | 59 | 1 | 3 | 39 | 2 | 5 | 79 | 1 | 5 | 69 | 2 | 6 |
| Rotate Right Thru Carry | ROR | 46 | 1 | 3 | 56 | 1 | 3 | 36 | 2 | 5 | 76 | 1 | 5 | 66 | 2 | 6 |
| Logical Shift Left | LSL | 48 | 1 | 3 | 58 | 1 | 3 | 38 | 2 | 5 | 78 | 1 | 5 | 68 | 2 | 6 |
| Logical Shift Right | LSR | 44 | 1 | 3 | 54 | 1 | 3 | 34 | 2 | 5 | 74 | 1 | 5 | 64 | 2 | 6 |
| Arithmetic Shift Right | ASR | 47 | 1 | 3 | 57 | 1 | 3 | 37 | 2 | 5 | 17 | 1 | 5 | 67 | 2 | 6 |
| Test for Negative or Zero | TST | 4D | 1 | 3 | 5D | 1 | 3 | 3D | 2 | 4 | 7D | 1 | 4 | 6D | 2 | 5 |

TABLE 6 - BRANCH INSTRUCTIONS

| | | Relative Addressing Mod | | | | | | |
|--|----------|-------------------------|------------|-------------|--|--|--|--|
| Function | Mnemonic | Op Code | # Bytes | # Cycles | | | | |
| Branch Always | BRA | 20 | 2 | 3 | | | | |
| Branch Never | BRN | 21 | 2 | 3 | | | | |
| Branch IFF Higher | ВНІ | 22 | 2 | 3 | | | | |
| Branch IFF Lower or Same | BLS | 23 | 2 | 3 | | | | |
| Branch IFF Carry Clear | BCC | 24 | 2 | 3 | | | | |
| (Branch IFF Higher or Same) | (BHS) | 24 | 2 | 3 | | | | |
| Branch IFF Carry Set | BCS | 25 | 2 | 3 | | | | |
| (Branch IFF Lower) | (BLO) | 25 | 2 | 3 | | | | |
| Branch IFF Not Equal | BNE | 26 | 2 | 3 | | | | |
| Branch IFF Equal | BEQ | 27 | 2 | 3 | | | | |
| Branch IFF Half Carry Clear | внсс | 28 | 2 | 3 | | | | |
| Branch IFF Half Carry Set | BHCS | 29 | 2 | 3 | | | | |
| Branch IFF Plus | BPL | 2A | 2 | 3 | | | | |
| Branch IFF Minus | BMI | 2B | 2 | 3 | | | | |
| Branch IFF Interrupt Mask Bit is Clear | ВМС | 2C | 2 | 3 | | | | |
| Branch IFF Interrupt Mask Bit is Set | BMS | 2D | 2 | 3 | | | | |
| Branch IFF Interrupt Line is Low | BIL | 2E | 2 | 3 | | | | |
| Branch IFF Interrupt Line is High | BIH | 2F | 2 | 3 | | | | |
| Branch to Subroutine | BSR | AD | 2 | 6 | | | | |

TABLE 7 - BIT MANIPULATION INSTRUCTIONS

| | | Addressing Modes | | | | | | | | | | |
|---------------------------|-------------------|------------------|-----------------------------------|-------------|------------|------------|-------------|--|--|--|--|--|
| | | Ві | Bit Set/Clear Bit Test and Branch | | | | | | | | | |
| Function | Mnemonic | Op Code | # Bytes | # Cycles | Op Code | # Bytes | # Cycles | | | | | |
| Branch IFF Bit n is Set | BRSET n (n = 0 7) | _ | _ | _ | 2•n | 3 | 5 | | | | | |
| Branch IFF Bit n is Clear | BRCLR n (n=0 7) | | _ | _ | 01 + 2•n | 3 | 5 | | | | | |
| Set Bit n | BSET n (n=0 7) | 10+2•n | 2 | 5 | _ | - | _ | | | | | |
| Clear Bit n | BCLR n (n=0 7) | 11 + 2•n | 2 | 5 | _ | _ | _ | | | | | |

TABLE 8 - CONTROL INSTRUCTIONS

| | | | Inherent | |
|--------------------------|----------|------------|------------|-------------|
| Function | Mnemonic | Op Code | # Bytes | # Cycles |
| Transfer A to X | TAX | 97 | 1 | 2 |
| Transfer X to A | TXA | 9F | 1 | 2 |
| Set Carry Bit | SEC | 99 | 1 | 2 |
| Clear Carry Bit | CLC | 98 | 1 | 2 |
| Set Interrupt Mask Bit | SEI | 9B | 1 | 2 |
| Clear Interrupt Mask Bit | CLI | 9A | 1 | 2 |
| Software Interrupt | SWI | 83 | 1 | 10 |
| Return from Subroutine | RTS | 81 | 1 | 6 |
| Return from Interrupt | RTI | 80 | 1 | 9 |
| Reset Stack Pointer | RSP | 9C | 1 | 2 |
| No-Operation | NOP | 9D | 1 | 2 |
| Stop | STOP | 8E | 1 | 2 |
| Wait | WAIT | 8F | 1 | 2 |

TABLE 9 - INSTRUCTION SET

| | r | | | | ddressing | Modes | ·E I | | | | Co | ndit | ior | Co | des |
|------------|---------------------------------------|--------------|-----------------|---------------|--------------|--|---------------------|--|---------------|---------------|----|------|------|----------|-------|
| | | | | ^ | duressing | | | | Bit | Bit | - | T | 1011 | | 105 |
| Mnemonic | Inherent | Immediate | Direct | Extended | Relative | Indexed (No Offset) | Indexed (8 Bits) | Indexed (16 Bits) | Set/ Clear | Test & Branch | н | ١ | N | L | С |
| ADC | | X | X | X | | X | X | X | | | Λ | • | Λ | | Λ |
| ADD | | X | X | X | | X | X | X | | | Λ | • | | Λ | Λ |
| AND ASL | × | X | X | X | | X | X | × | l | | • | • | Λ | Λ | Λ |
| ASR | - x | | x | | | x | × | | | | - | • | Λ | A | A |
| BCC | · · · · · · | | <u> </u> | | X | ° | | | | | • | • | • | • | • |
| BCLR | | | | | | | | | X | | • | • | • | • | • |
| BCS | | | | | X | | | | | | • | • | • | • | • |
| BEQ | | | | | Х | | | | | | • | • | • | • | • |
| BHCC | | | | | X | ļ | | | | | | • | • | • | • |
| BHCS | | | | | X | | | ļ | - | | • | • | • | • | • |
| BHS | | | | | × | | | | | | • | • | | - | 1 |
| BIH | | | | | x | | | | | | • | • | • | • | 1 |
| BIL | | | | | X | | | | | | • | • | • | • | • |
| BIT | | × | X | X | | X | Х | X | | | • | • | Λ | | • |
| BLO | | | | | X | | | | | | • | • | • | | • |
| BLS | | | | | X | | | | | | • | • | • | • | • |
| BMC | | | | | X | | | | | | • | • | • | • | • |
| BMI | ļ | | | | X | | | | | | • | • | • | • | • |
| BMS BNE | | | | | × | | | | | | - | • | - | • | - |
| BPL | | | | ļ | x | | | | | | - | • | • | • | - |
| BRA | | | | | × | | | | | | • | • | • | • | • |
| BRN | | | | | X | | | | | | • | • | • | • | • |
| BRCLR | | | | | | | | | | X | | • | • | • | Λ |
| BRSET | | | | | | | | | | X | • | • | • | • | Λ |
| BSET | | | | | | | | | Х | | • | • | • | • | • |
| BSR | | | | | X | | | | | | • | • | • | • | • |
| CLC | X | | | | | | | | | | • | • | • | • | 0 |
| CLI | X | | × | | | × | X | | | | • | 0 | | 1 | • |
| CMP | | × | x | × | | - x | - x | X | | | • | • | A | | Ā |
| COM | X | | x | | | × | X | <u>^</u> - | | | • | • | Λ | | 11 |
| CPX | · · · · · · · · · · · · · · · · · · · | × | X | X | | × | X | X | | | • | • | | | Λ |
| DEC | X | | Х | | | X | X | | | | • | • | Λ | | • |
| EOR | | X | Х | X | | X | Х | Х | | | • | • | Λ | | • |
| INC | X | | X | | | X | X | | | | | • | Λ | | • |
| JMP | | | X | X | | X | X | X | | | • | • | • | • | • |
| JSR LDA | | × | X | X | ļ | X | X | X | | ļ | • | • | Δ | Λ | • |
| LDX | | X | X | X | | X | X | × | | | • | - | A | | - |
| LSL | X | | x | ^ | | - x | × | ^ | | | • | • | Λ | | Λ |
| LSR | X | | X | | | × | X | · | | | • | • | 0 | Λ | Λ |
| NEG | X | | X | | | × | X | | | | • | • | Λ | Λ | Λ |
| NOP | X | | | | | | | | | | • | • | • | • | • |
| ORA | | X | Х | X | | X | Х | Х | | | • | • | Λ | Λ | • |
| ROL | X | | X | | | X | X | | | | • | • | Λ | | A |
| ROR | X | | Х | | ļ | Х | Х | | | | • | • | Λ | | Λ |
| RSP RTI | X | | | ļ | ļ | | | | | | 7 | • | 7 | - | 1 |
| RTS | X | | | | | | | | | ļ | • | 6 | • | • | • |
| SBC | | × | × | X | | × | X | × | | | • | • | Λ | | Λ |
| SEC | × | · · · · · | · · · · · · | · · · · · · | | | | | | | | • | • | | 1 |
| SEI | X | | | | | | | | | | | 1 | • | • | • |
| STA | | | Х | X | | X | X | Х | | | • | • | Λ | | |
| STOP | X | | | | | | | | | | • | 0 | • | • | • |
| STX | | | X | X | | X | X | X | | | • | • | Λ | | |
| SUB | | X | Х | X | ļ | × | X | X | ļ | | • | • | Λ | Λ | |
| SWI | X | | | | ļ | | | | | | • | 1 | • | • | • |
| TAX TST | X | | × | | | × | × | | | | • | • | Λ | Ā | |
| TXA | × | | ^ | | | ^ | | | | | • | - | • | • | |
| WAIT | x | | | | l | | | | - | · | • | 0 | | • | |
| ****** | | L | L | L | L | | L | L | | | | L | | <u> </u> | بَـــ |

Condition Code Symbols

- H Half Carry (From Bit 3) Interrupt Mask N Negative (Sign Bit) Z Zero C Carry/Borrow

- A Test and Set if True Cleared Otherwise
 Not Affected
 Property Load CC Register From Stack

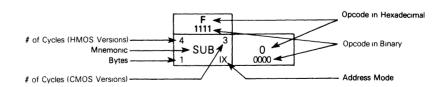
- 0 Cleared 1 Set

TABLE 10 - MC6805/MC146805 INSTRUCTION SET OPCODE MAP

| | Bit Ma | nipulation | Branch | | Re | ad/Modify/ | Write | | Control Register/Memory | | | | | | | | T |
|-----------|-----------------|------------------|--------------|----------------|---------------|---------------|-----------|-----------|-------------------------|---------------------|----------------|----------------|----------------|----------------|----------------|--------|-----------|
| 1 | BTB | BSC | REL | DIR | INH(A) | INH(X) | IX1 | IX | INH | INH | IMM | DIR | EXT | IX2 | IX1 | IX | 1 |
| Low | 0000 | 0001 | 0010 | 3 0011 | 0100 | 5 0101 | 6 0110 | 7 0111 | 1000 | 9 1001 | 1010 | B 1011 | 1100 | D 1101 | 1110 | 1111 | Hi |
| 0000 | BRSETO 3 BTB | BSETO 5 | BRA | NEG | NEGA 1 INH | NEGX 1 INH | NEG 1X1 | NEG 1 IX | RTI 1 INH | | SUB 2 2 IMM | SUB 2 DIR | SUB 3 EXT | SUB 5 | SUB 1X1 | SUB 3 | |
| 1 0001 | BRCLRO 3 BTB | BCLR0 5 2 BSC | BRN | | | | | | RTS 1 INH | | CMP 2 | CMP 2 DIR | CMP 3 EXT | CMP 3 1X2 | CMP IX1 | CMP IX | 1 0001 |
| 2 0010 | BRSET1 3 BTB | BSET1 2 BSC | BHI 2 REL | | | | | | | | SBC 2 | SBC 3 | SBC SBC | | SBC 4 | SBC 3 | 2 0010 |
| 3 0011 | BRCLR1 3 BTB | BCLR1 2 BSC | BLS REL | COM 5 2 DIR | COMA 3 | COMX 3 | COM 6 | COM 5 | SWI 1 INH | | CPX 2 IMM | CPX 3 | CPX 3 EXT | CPX 5 | CPX 4 2 IX1 | CPX 3 | 3 0011 |
| 4 0100 | BRSET2 3 BTB | BSET2 2 BSC | BCC REL | LSR 5 | LSRA 1 INH | LSRX 1 INH | LSR 2 IX1 | LSR 5 | | | AND 2 | AND DIR | AND 3 EXT | AND 3 IX2 | AND 1X1 | AND 1X | 4 0100 |
| 5 0101 | BRCLR2 3 BTB | BCLR2 5 2 BSC | | | | | | | | | BIT 2 | BIT 2 DIR | BIT 3 EXT | BIT 3 | BIT 2 IX1 | BIT IX | 5 0101 |
| 6 0110 | BRSET3 3 BTB | BSET3 BSC | BNE REL | ROR DIR | RORA 3 | RORX 3 | ROR 1X1 | ROR 1 IX | | | LDA 2 IMM | LDA 2 DIR | LDA 3 EXT | | LDA 1X1 | LDA 3 | 6 0110 |
| 7 0111 | BRCLR3 3 BTB | BCLR3 2 BSC | BEQ REL | ASR DIR | ASRA 1 INH | 'ASRX 1 | ASR 2 IX1 | ASR 1 | | TAX | | STA DIR | STA 3 EXT | STA 3 IX2 | STA 1X1 | STA 1X | 7 0111 |
| 8 | BRSET4 3 BTB | BSET4 2 BSC | BHCC 3 | LSL 2 DIR | LSLA 1 INH | LSLX 1 INH | LSL 6 | LSL 5 | | CLC 1 NH | EOR 2 | | EOR 3 EXT | 6 EOR 3 IX2 | EOR 2 | EOR IX | 8 1000 |
| 9 | BRCLR4 3 BTB | BCLR4 2 BSC | BHCS | ROL 2 DIR | ROLA 1 INH | ROLX 1 INH | ROL 1X1 | ROL 1 | | SEC 1 INH | ADC 2 | | ADC 3 EXT | | ADC 1X1 | ADC 3 | 9 1001 |
| A 1010 | BRSET5 3 BTB | BSET5 2 BSC | BPL REL | DEC 5 2 DIR | DECA 1 INH | DECX 1 INH | DEC 1X1 | DEC 1 IX | | 2 2 CLI 1 INH | ORA 2 IMM | | ORA 3 EXT | ORA 3 IX2 | ORA 2 IX1 | ORA 1 | A 1010 |
| B 1011 | BRCLR5 3 BTB | BCLR5 2 BSC | BMI 2 REL | | | | | | | SEI 1 INH | ADD 2 | ADD 3 | ADD 4 3 EXT | ADD 5 | ADD 1X1 | ADD 3 | B '011 |
| C 1100 | BRSET6 3 BTB | BSET6 2 BSC | BMC REL | INC DIR | INCA 1 INH | INCX 1 INH | INC 6 | INC 1 IX | | 2 RSP 1 INH | | JMP 2 2 DIR | JMP 3 EXT | JMP 3 IX2 | JMP 1X1 | JMP 1 | C 1100 |
| D 1101 | BRCLR6 3 BTB | BCLR6 2 BSC | BMS REL | TST DIR | TSTA 1 INH | TSTX 1 INH | TST 2 IX1 | TST 4 | | NOP INH | BSR 2 REL | JSR 2 DIR | JSR 3 EXT | JSR 3 IX2 | JSR 2 IX1 | JSR 5 | D 1101 |
| E 1110 | BRSET7 3 BTB | BSET7 2 BSC | BIL 3 | | | | | | STOP 2 | | LDX 2 IMM | LDX 2 DIR | LDX 3 EXT | | LDX 2 IX1 | LDX 3 | E 1110 |
| F 1111 | BRCLR7 3 BTB | BCLR7 2 BSC | BIH REL | CLR DIR | CLRA 1 INH | CLRX 1 INH | CLR 1X1 | CLR 1 | WAIT 1 INH | TXA 1 INH | | STX DIR | STX 3 EXT | STX 1X2 | STX 5 | STX 4 | F 1'11 |

Abbreviations for Address Modes

INH Inherent IMM Immediate DIR Direct EXT Extended REL Relative BSC Bit Set/Clear втв Bit Test and Branch IX Indexed (No Offset) IX1 Indexed, 1 Byte (8-Bit) Offset IX2 Indexed, 2 Byte (16-Bit) Offset **CMOS Versions Only**



LEGEND

Indexed, 8-bit Offset — Here the EA is obtained by adding the contents of the byte following the opcode to that of the index register. The operand is therefore located anywhere within the lowest 511 memory locations. For example, this mode of addressing is useful for selecting the m-th element in an n element table. All instructions are two bytes. The contents of the index register (X) is not changed. The contents of (PC+1) is an unsigned 8-bit integer. One byte offset indexing permits look-up tables to be easily accessed in either RAM or ROM.

EA = X + (PC + 1), $PC \leftarrow PC + 2$ Address Bus High $\leftarrow K$; Address Bus Low $\leftarrow X + (PC + 1)$ Where $\cdot K =$ The carry from the addition of X + (PC + 1)

Indexed, 16-Bit Offset — In the indexed, 16-bit offset addressing mode the effective address is the sum of the contents of the unsigned 8-bit index register and the two unsigned bytes following the opcode. This addressing mode can be used in a manner similar to indexed 8-bit offset, except that this three byte instruction allows tables to be anywhere in memory (e.g., jump tables in ROM). As with direct and extended, the M6805 assembler determines the most efficient form of indexed offset — 8 or 16 bit. The content of the index register is not changed.

EA = X + [(PC + 1) (PC + 2)], PC - PC + 3Address Bus High - (PC + 1) + K; Address Bus Low - X + (PC + 2)Where K = The carry from the addition of <math>X + (PC + 2)

Relative — Relative addressing is only used in branch instructions. In relative addressing the contents of the 8-bit signed byte following the opcode (the offset) is added to the PC if and only if the branch condition is true. Otherwise, control proceeds to the next instruction. The span of relative addressing is limited to the range of -126 to +129 bytes from the branch instruction opcode location. The Motorola assembler calculates the proper offset and checks to see if it

is within the span of the branch

EA = PC + 2 + (PC + 1); $PC \leftarrow EA$ if branch taken, otherwise $PC \leftarrow PC + 2$

Bit Set/Clear — Direct addressing and bit addressing are combined in instructions which set and clear individual memory and I/O bits. In the bit set and clear instructions, the byte is specified as a direct address in the location following the opcode. The first 256 addressable locations are thus accessed. The bit to be modified within that byte is specified with three bits of the opcode. The bit set and clear instructions occupy two bytes, one for the opcode (including the bit number) and the second to address the byte which contains the bit of interest.

 $EA = (PC + 1), PC \leftarrow PC + 2$ Address Bus High \(\lefta 0; Address Bus Low \lefta (PC + 1)

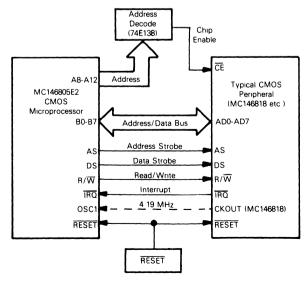
Bit Test and Branch — Bit test and branch is a combination of direct addressing, bit addressing and relative addressing. The bit address and condition (set or clear) to be tested is part of the opcode. The address of the byte to be tested is in the single byte immediately following the opcode byte (EA1). The signed relative 8-bit offset is in the third byte (EA2) and is added to the PC if the specified bit is set or clear in the specified memory location. This single three byte instruction allows the program to branch based on the condition of any bit in the first 256 locations of memory.

EA1 = (PC+1)
Address Bus High-0, Address Bus Low-(PC+1)
EA2 = PC+3+(PC+2); PC-EA2 if branch taken,
otherwise PC-PC+3

SYSTEM CONFIGURATION

Figures 20 through 25 show in general terms how the MC148805E2 bus structure may be utilized. Specified interface details vary with the various peripheral and memory devices employed.

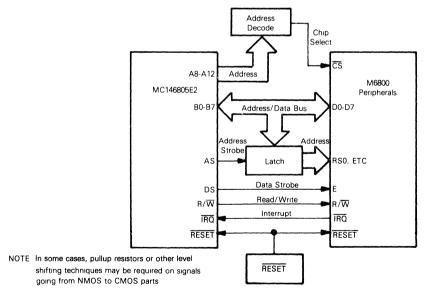




Address Decode Chip Enable MC146805E2 CMOS Multiplexed A8-A12 Memory Address A10 (MCM65516) B0-B7 Address/Data Bus ADQ0-ADQ7 Address Strobe AS Data Strobe DS Read/Write R/W

FIGURE 21 — CONNECTION TO CMOS MULTIPLEXED MEMORIES

FIGURE 22 - CONNECTION TO M6800 PERIPHERALS



B0-B7 Address/Data Bus Data Q0-Q7 CMOS MC146805E2 Non-Muxed A0-A7 ROM or Address **EPROM** A8-A12 Address Α8 Output Read/ Write Read Enable Address R/W Ī Decode Data Strobe DS Chip Address Enable Strobe

FIGURE 23 - CONNECTION TO LATCHED NON-MULTIPLEXED CMOS ROM AND EPROM

FIGURE 24 — CONNECTION TO STATIC CMOS RAMS

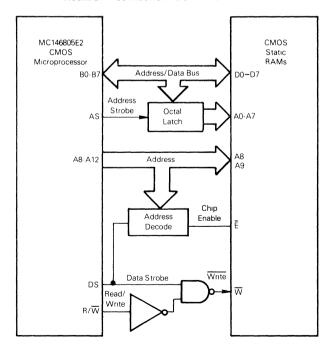


FIGURE 25 - CONNECTION TO LATCHED NON-MULTIPLEXED CMOS RAM

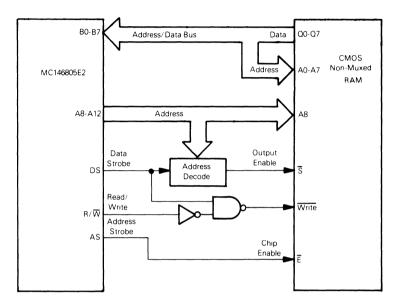


Table 11 provides a detailed description of the information present on the Bus, the Read/Write (R/\overline{W}) pin and the Load Instruction (LI) pin during each cycle for each instruction This information is useful in comparing actual with ex-

pected results during debug of both software and hardware as the control program is executed. The information is categorized in groups according to addressing mode and number of cycles per instruction

TABLE 11 - SUMMARY OF CYCLE BY CYCLE OPERATION

| Address Mode | Cycles | Cycle # | Address Bus | R/W | LI | Data Bus |
|---------------------|-------------|---------|------------------------------------|--------------|-------------|---------------------------------------|
| Instructions | Cycles | Cycle # | Address Bus | Pin | Pin | Data Bus |
| Inherent | | | | | | · · · · · · · · · · · · · · · · · · · |
| LSR LSL | | | | T | T | |
| ASR NEG | ĺ | 1 | Op Code Address | 1 1 | 1 | Op Code |
| CLR ROL | 3 | 2 | Op Code Address +1 | 1 1 | ا o | Op Code Next Instruction |
| COM ROR | 1 | 3 | Op Code Address +1 | l i | Ö | Op Code Next Instruction |
| DEC INC TST | | ٦ | Op code Address +1 | [' | " | Op code Next matraction |
| | | ļ | | | | |
| TAX CLC SEC | | 1 | Op Code Address | 1 1 | 1 | Op Code |
| STOP CLI SEI | 2 | 2 | Op Code Address +1 | l i | o | Op Code Next Instruction |
| RSP WAIT NOP TXA | | | | <u> </u> | | op doub not motioned |
| | i | 1 | Op Code Address | 1 1 | 1 | Op Code |
| | | 2 | Op Code Address +1 | 1 | 0 | Op Code Next Instruction |
| DTO | | 3 | Stack Pointer | 1 | 0 | Irrelevant Data |
| RTS | 6 | 4 | Stack Pointer +1 | 1 | 0 | Irrelevant Data |
| | | 5 | Stack Pointer + 2 | 1 | 0 | Irrelevant Data |
| | 1 | 6 | New Op Code Address | 1 1 | 0 | New Op Code |
| | + | 1 | Op Code Address | 1 | 1 | Op Code |
| | 1 | 2 | Op Code Address +1 | 1 . | 0 | Op Code Next Instruction |
| | 1 | 3 | | 1 0 | | |
| | ſ | 4 | Stack Pointer | | 0 | Return Address (LO Byte) |
| 1 | 1 | | Stack Pointer - 1 | 0 | 1 - | Return Address (HI Byte) |
| swi | 10 | 5 | Stack Pointer - 2 | 0 | 0 | Contents of Index Register |
| | | 6 | Stack Pointer -3 | 0 | 0 | Contents of Accumulator |
| | 1 | 7 | Stack Pointer -4 | 0 | 0 | Contents of CC Register |
| | | 8 | Vector Address 1FFC (Hex) | 1 | 0 | Address of Int. Routine (HI Byte) |
| | 1 . | 6 | Vector Address 1FFD (Hex) | 1 | 0 | Address of Int. Routine (LO Byte |
| | 1 | 10 | Interrupt Routine Starting Address | 1 | 0 | Interrupt Routine First Opcode |
| | | 1 | Op Code Address | 1 | 1 | Op Code |
| 1 | 1 : | 2 | Op Code Address +1 | 1 | o | Op Code Next Instruction |
| | | 3 | Stack Pointer | l i | 0 | Irrelevant Data |
| | | 4 | Stack Pointer + 1 | 1 1 | 0 | Irrelevant Data |
| RTI | 9 | 5 | Stack Pointer + 1 | 1 . | 0 | Irrelevant Data |
| nii | 9 | | | 1 ! | | |
| | 1 | 6 | Stack Pointer +3 | 1 | 0 | Irrelevant Data |
| | | 7 | Stack Pointer +4 | 1 | 0 | Irrelevant Data |
| | | 8 | Stack Pointer +5 | 1 | 0 | Irrelevant Data |
| | | 9 | New Op Code Address | 1 | 0 | New Op Code |
| Immediate | | | | | | |
| ADC EOR CPX | | | | T | | |
| ADD LDA LDX | | 1 | Op Code Address | 1 | 1 | Op Code |
| AND ORA BIT | 2 | 2 | Op Code Address +1 | l i | Ö | Operand Data |
| SBC CMB SUB | 1 | _ | op code Address 1 1 | 1 ' | | operana bata |
| Bit Set/Clear | | | <u> </u> | J | L | L |
| Bit Set/ Clear | | | | , | ···· | |
| | | 1 | Op Code Address | 1 | 1 | Op Code |
| BSET n | 1 1 | 2 | Op Code Address +1 | 1 | 0 | Address of Operand |
| BCLR n | 5 | 3 | Address of Operand | 1 | 0 | Operand Data |
| BCEN II | 1 | 4 | Address of Operand | 1 | 0 | Operand Data |
| | 1 ' | 5 | Address of Operand | 0 | 0 | Manipulated Data |
| Bit Test and Branch | | | | | | |
| | — | 1 | On Code Address | 1 | 1 | On Code |
| | | 1 | Op Code Address | 1 | 1 | Op Code |
| BRSET n | _ | 2 | Op Code Address + 1 | 1 1 | 0 | Address of Operand |
| BRCLR n | 5 | 3 | Address of Operand | 1 | 0 | Operand Data |
| | | 4 | Op Code Address +2 | 1 | 0 | Branch Offset |
| | | 5 | Op Code Address +2 | 11 | 0 | Branch Offset |
| Relative | | | | | | |
| BCC BHI BNE BEQ | | | | | | |
| BCS BPL BHCC BLS | | 1 | Op Code Address | 1 | 1 | Op Code |
| BIL BMC BRN BHCS | 3 | 2 | Op Code Address +1 | 1 | 0 | Branch Offset |
| BIH BMI BMS BRA | | 3 | Op Code Address +1 | 1 | 0 | Branch Offset |
| CIT DIVIT DIVIS DRA | | | 0.01.411 | | | 0-0-1- |
| | | 1 | Op Code Address | 1 | 1 | Op Code |
| | | 2 | Op Code Address +1 | 1 | 0 | Branch Offset |
| BSR | 6 | 3 | Op Code Address +1 | 1 | 0 | Branch Offset |
| | " | 4 | Subroutine Starting Address | 1 | 0 | First Subroutine Op Code |
| | 1 1 | 5 | Stack Pointer | 0 | 0 | Return Address (LO Byte) |
| | | 6 | Stack Pointer - 1 | 1 0 | 0 | Return Address (HI Byte) |

TABLE 11 - SUMMARY OF CYCLE BY CYCLE OPERATION (CONTINUED)

| Address Made | IABLE | I – SUN | IMARY OF CYCLE BY CYCLE OPERATION I | T | | |
|------------------------------|-------------|----------|---|--|-----------|---|
| Address Mode Instructions | Cycles | Cycles # | Address Bus | R/W Pin | LI Pin | Data Bus |
| Direct | | L | | FIII | <u> </u> | |
| Dilect | | 1 | Op Code Address | 1 1 | 1 | Op Code |
| JMP | 2 | 1 2 | Op Code Address + 1 | ; | Ó | Jump Address |
| ADC EOR CPX | | | | t | | |
| ADD LDA LDX | | 1 | Op Code Address | 1 1 | 1 | Op Code |
| AND ORA BIT | 3 | 2 | Op Code Address + 1 | 1 | 0 | Address of Operand |
| SBC CMP SUB | | 3 | Address of Operand | 1 | 0 | Operand Data |
| | | 1 | Op Code Address | 1 | 1 | Op Code |
| TST | 4 | 2 | Op Code Address +1 | 1 1 | 0 | Address of Operand |
| 151 | " | 3 | Address of Operand | 1 | 0 | Operand Data |
| | | 4 | Op Code Address + 2 | 1 | 0 | Op Code Next Instruction |
| | | 1 | Op Code Address | 1 | 1 | Op Code |
| STA | 4 | 2 | Op Code Adrress +1 | 1 1 | 0 | Address of Operand |
| STX | - | 3 | Op Code Address +1 | 1 | 0 | Address of Operand |
| | | 4 | Address of Operand | 0 | 0 | Operand Data |
| LSL LSR DEC | | 1 | Op Code Address | 1 1 | 1 | Op Code |
| ASR NEG INC | _ | 2 | Op Code Address +1 | 1 ! | 0 | Address of Operand |
| CLR ROL | 5 | 3 | Operand Address | ! | 0 | Current Operand Data Current Operand Data |
| COM ROR | | 4 5 | Operand Address Operand Address | 1 0 | 0 | New Operand Data |
| | | 1 | Op Code Address | 1 1 | 1 | Op Code |
| | | 2 | Op Code Address + 1 | 1 1 | Ó | Subroutine Address (LO Byte) |
| JSR | 5 | 3 | Subroutine Starting Address | i | Ö | 1st Subroutine Op Code |
| 3311 | | 4 | Stack Pointer | ا ہ ا | ő | Return Address (LO Byte) |
| | İ | 5 | Stack Pointer - 1 | 0 | 0 | Return Address (HI Byte) |
| Extended | | | | | | |
| | | 1 | Op Code Address | 1 | 1 | Op Code |
| JMP | 3 | 2 | Op Code Address +1 | 1 | 0 | Jump Address (HI Byte) |
| | | 3 | Op Code Address + 2 | 1 | 0 | Jump Address (LO Byte) |
| ADC BIT ORA | | 1 | Op Code Address | 1 | 1 | Op Code |
| ADD CMP LDX | 4 | 2 | Op Code Address +1 | 1 1 | 0 | Address Operand (HI Byte) |
| AND EOR SBC | 4 | 3 | Op Code Address +2 | 1 | 0 | Address Operand (LO Byte) |
| CPX LDA SUB | | 4 | Address of Operand | 1 | 0 | Operand Data |
| | | 1 | Op Code Address | 1 | 1 | Op Code |
| STA | | 2 | Op Code Address +1 | 1 | 0 | Address of Operand (HI Byte) |
| STX | 5 | 3 | Op Code Address + 2 | 1 | 0 | Address of Operand (LO Byte) |
| | | 4 5 | Op Code Address + 2 Address of Operand | 1 0 | 0 | Address of Operand (LO Byte) Operand Data |
| | | | | | | |
| | ì | 1 2 | Op Code Address Op Code Address + 1 | 1 | 1 | Op Code Address of Subroutine (HI Byte) |
| | İ | 3 | Op Code Address + 1 | i | 0 | Address of Subroutine (LO Byte) |
| JSR | 6 | 4 | Subroutine Starting Address | l i l | Ö | 1st Subroutine Op Code |
| | | 5 | Stack Pointer | 0 | 0 | Return Address (LO Byte) |
| | | 6 | Stack Pointer - 1 | 0 | 0 | Return Address (HI Byte) |
| Indexed, No-Offset | | | | | | |
| JMP | 2 | 1 | Op Code Address | 1 | 1 | Op Code |
| Jivir | | 2 | Op Code Address + 1 | 1 | 0 | Op Code Next Instruction |
| ADC EOR CPX | | 1 | Op Code Address | 1 | 1 | Op Code |
| ADD LDA LDX | 3 | 2 | Op Code Address + 1 | 1 1 | ò | Op Code Next Instruction |
| AND ORA BIT | 1 | 3 | Index Register | 1 1 | 0 | Operand Data |
| SBC CMP SUB | | | | | | |
| | į. | 1 | Op Code Address | 1 1 | 1 | Op Code |
| TST | 4 | 2 | Op Code Address + 1 Index Register | 1 1 | 0 | Op Code Next Instruction Operand Data |
| | 1 | 4 | Op Code Address + 1 | | 0 | Op Code Next Instruction |
| | | 1 | Op Code Address | 1 | 1 | Op Code |
| STA | 1 | 2 | Op Code Address + 1 | | 0 | Op Code Next Instruction |
| STX | 4 | 3 | Op Code Address + 1 | i | ő | Op Code Next Instruction |
| | | 4 | Index Register | 0 | ő | Operand Data |
| | | 1 | Op Code Address | 1 | 1 | Op Code |
| LSL LSR DEC | | 2 | Op Code Address + 1 | l i | Ö | Op Code Next Instruction |
| ASR NEG INC CLR ROL | 5 | 3 | Index Register | 1 | Ō | Current Operand Data |
| COM ROR | 1 | 4 | Index Register | 1 | 0 | Current Operand Data |
| OOW HOLL | | 5 | Index Register | 0 | 0 | New Operand Data |
| | | 1 | Op Code Address | 1 | 1 | Op Code |
| | | 2 | Op Code Address +1 | 1 1 | 0 | Op Code Next Instruction |
| JSR | 5 | 3 | Index Register | 1 | 0 | 1st Subroutine Op Code |
| | | 4 | Stack Pointer | 0 | 0 | Return Address (LO Byte) |
| L | | 5 | Stack Pointer - 1 | 0 | 0 | Return Address (HI Byte) |

TABLE 11 - SUMMARY OF CYCLE BY CYCLE OPERATION (CONTINUED)

| Address Mode | Cycles | Cycles # | Address Bus | R/W | LI | Data Bus |
|------------------------|--------|----------|---------------------------------|-----|-----|----------------------------------|
| Instructions | | | | Pin | Pin | |
| Indexed 8-Bit Offset | | | | , | | · |
| | ł | 1 | Op Code Address | 1 1 | 1 | Op Code |
| JMP | 3 | 2 | Op Code Address +1 | 1 | 0 | Offset |
| | | 3 | Op Code Address +1 | 1 | 0 | Offset |
| ADC EOR CPX | | 1 | Op Code Address | 1 | 1 | Op Code |
| ADD LDA LDX | 4 | 2 | Op Code Address +1 | 1 1 | 0 | Offset |
| AND ORA CMP | 4 | 3 | Op Code Address +1 | 1 1 | 0 | Offset |
| SUB BIT SBC | 1 | 4 | Index Register + Offset | 1 1 | 0 | Operand Data |
| | | 1 | Op Code Address | 1 | 1 | Op Code |
| | 1 | 2 | Op Code Address +1 | 1 1 | 0 | Offset |
| STA | 5 | 3 | Op Code Address +1 | 1 1 | ō | Offset |
| STX | | 4 | Op Code Address +1 | 1 1 | ō | Offset |
| | 1 | 5 | Index Register + Offset | 0 | 0 | Operand Data |
| | | 1 | Op Code Address | 1 | 1 | Op Code |
| | 1 | 2 | Op Code Address +1 | 1 1 | ò | Offset |
| TST | 5 | 3 | Op Code Address +1 | lil | 0 | Offset |
| | 1 | 4 | Index Register + Offset | lil | 0 | Operand Data |
| | 1 | 5 | Op Code Address +2 | lil | ő | Op Code Next Instruction |
| | | 1 | Op Code Address | 1 | 1 | Op Code |
| LSL LSR | 1 | 2 | Op Code Address + 1 | | 0 | Offset |
| ASR NEG | | 3 | Op Code Address + 1 | | 0 | Offset |
| CLR ROL | 6 | 4 | Index Register + Offset | | 0 | Current Operand Data |
| COM ROR | 1 | 5 | Index Register + Offset | | 0 | Current Operand Data |
| DEC INC | 1 | 6 | Index Register + Offset | 0 | 0 | New Operand Data |
| | | | | | | |
| | 1 | 1 | Op Code Address | 1 1 | 1 | Op Code |
| | 1 | 2 | Op Code Address + 1 | 1 1 | 0 | Offset |
| JSR | 6 | 3 | Op Code Address +1 | | 0 | Offset 1st Subroutine Op Code |
| | | 4 5 | Index Register + Offset | | 0 | Return Address LO Byte |
| | | 6 | Stack Pointer Stack Pointer - 1 | 0 | 0 | Return Address LO Byte |
| | | 0 | Stack Pointer - 1 | | | Return Address Hi Byte |
| Indexed, 16-Bit Offset | | | | | | γ |
| | 1 : | 1 | Op Code Address | 1 1 | 1 | Op Code |
| JMP | 4 | 2 | Op Code Address +1 | 1 1 | 0 | Offset (HI Byte) |
| 31411 | 1 7 | 3 | Op Code Address +2 | 1 1 | 0 | Offset (LO Byte) |
| | | 4 | Op Code Address +2 | 1 | 0 | Offset (LO Byte) |
| ADC CMP SUB | | 1 | Op Code Address | 1 | 1 | Op Code |
| ADD EOR SBC | | 2 | Op Code Address +1 | 1 1 | 0 | Offset (HI Byte) |
| AND ORA | 5 | 3 | Op Code Address +2 | 1 | 0 | Offset (LO Byte) |
| CPX LDA | | 4 | Op Code Address +2 | 1 1 | 0 | Offset (LO Byte) |
| BIT LDX | | 5 | Index Register + Offset | 1 | 0 | Operand Data |
| | | 1 | Op Code Address | 1 | 1 | Op Code |
| | | 2 | Op Code Address +1 | 1 1 | 0 | Offset (HI Byte) |
| STA | | 3 | Op Code Address + 2 | 1 1 | 0 | Offset (LO Byte) |
| STX | 6 | 4 | Op Code Address + 2 | i | ŏ | Offset (LO Byte) |
| | | 5 | Op Code Address + 2 | 1 | 0 | Offset (LO Byte) |
| | 1 | 6 | Index Register + Offset | 0 | 0 | Operand Data |
| | | 1 | Op Code Address | 1 | 1 | Op Code |
| | 1 | 2 | Op Code Address +1 | i | Ö | Offset (HI Byte) |
| | 1 | 3 | Op Code Address + 2 | i | 0 | Offset (LO Byte) |
| JSR | 7 | 4 | Op Code Address +2 | | 0 | Offset (LO Byte) |
| | 1 ' | 5 | Index Register + Offset | 1 1 | 0 | 1st Subroutine Op Code |
| | | 6 | Stack Pointer | 0 | 0 | Return Address (LO Byte) |
| | | 7 | Stack Pointer – 1 | 0 | 0 | Return Address (HO Byte) |
| | | , | Stack Folliter = 1 | | | notani Addiess the byter |

TABLE 11 - SUMMARY OF CYCLE BY CYCLE OPERATION (CONTINUED)

| Instructions | Cycles | Cycles # | Address Bus | RESET Pin | R/W Pin | LI Pin | Data Bus |
|-------------------------------|--------|----------|---------------------------------------|--------------|------------|-----------|--------------------------|
| Other Functions | | | | | | | |
| | | | \$1FFE | 0 | 1 | 0 | Irrelevant Data |
| | | | \$1FFE | 0 | 1 | 0 | Irrelevant Data |
| | | 1 | \$1FFE | 1 | 1 | 0 | Irrelevant Data |
| Hardware RESET | 5 | 2 | \$1FFE | 1 | 1 | 0 | Irrelevant Data |
| | | 3 | \$1FFE | 1 | 1 | 0 | Vector High |
| | | 4 | \$1FFE | 1 | 1 | 0 | Vector Low |
| | | 5 | Reset Vector | 1 | 1 | 0 | Op Code |
| | | 1 | \$1FFE | 1 | 1 | 0 | Irrelevant Data |
| | | • | • | . • | • | • | • |
| | | • | • | • | • | • | • |
| Power on Reset | 1922 | • | • | • | • | • | • |
| rower on neset | 1922 | 1919 | \$1FFE | 1 | 1 | 0 | Irrelevant Data |
| | | 1920 | \$1FFE | 1 1 | 1 | 0 | Vector High |
| | 1 | 1921 | \$1FFF | 1 | 1 | 0 | Vector Low |
| | | 1922 | Reset Vector | 1 | 1 | 0 | Op Code |
| Instruction | Cycles | Cycles # | Address Bus | IRQ Pin | R/W Pin | LI Pin | Data Bus |
| | | | Last Cycle of Previous Instruction | 0 | Х | 0 | х |
| | | 1 | Next Op Code Address | 0 | 1 | 0 | Irrelevant Data |
| | | 2 | Next Op Code Address | X | 1 | 0 | Irrelevant Data |
| | | 3 | SP | X | 0 | 0 | Return Address (LO Byte) |
| IRQ Interrupt | 10 | 4 | SP – 1 | X | 0 | 0 | Return Address (HI Byte) |
| (Timer Vector \$1FF8, \$1FF9) | 10 | 5 | SP-2 | X | 0 | 0 | Contents Index Reg |
| | Ì | 6 | SP-3 | × | 0 | 0 | Contents Accumulator |
| | | 7 | SP – 4 | × | 0 | 0 | Contents CC Register |
| | Ì | 8 | \$1FFA | × | 1 | 0 | Vector High |
| | } | 9 | \$1FFB | × | 1 | 0 | Vector Low |
| | | 10 | IRQ Vector | × | 1 | 0 | Int Routine First |

APPENDIX

MC146805E2 INTERRUPT CLARIFICATION

Under certain circumstances, the MC146805E2 (BP4xxxx & AW9xxxx) 8-bit Microprocessor Unit IRQ interrupt does not conform to the operation described in this Advanced Information Sheet (ADI-850R1)

- The level sensitive IRQ mode, which is by far the most frequently used, is FULLY OPERATIONAL; thus, most MC146805E2 applications are unaffected However, the edge-triggered IRQ interrupt mode MIGHT NOT BE SERVICED under certain programming circumstances, therefore, it is recommended that the edge-triggered mode not be used.
- 2 An interrupt-vector address CAN BE improperly generated in some circumstances. There is a possibility that when an external interrupt (IRQ) and timer interrupt occur during the Wait mode (following a Wait instruction), address locations \$1FF2 and \$1FF3 are selected instead of vector locations \$1FF6 and \$1FF7. There are three specific examples listed below, two of

these require no action and the third has a recommended solution

- a Those not using the Wait mode need not take any
- b If the Wait mode is used without external interrupt (IRQ pin held high), no precautions are required.
- c . When IRQ can be active (low) during the Wait mode, the vector in locations \$1FF6 and \$1FF7 (the Wait mode Timer Interrupt Vector) should be duplicated in \$1FF2 and \$1FF3 In this way the circumstances that caused selection of the second vector do not disturb normal program execution

On future MC146805E2 parts, no special actions will be necessary. If you have questions, contact your Motorola distributor or Motorola sales office, or contact Motorola Microprocessor Applications Engineering in Austin, Texas.



MC146805F2

Product Preview

8-BIT MICROCOMPUTER UNIT

The MC146805F2 Microcomputer Unit (MCU) is a member of the M6805 Family of Microcomputers. This 8-bit fully static microcomputer contains a CPU, on-chip ROM, RAM, I/O, and timer. It is a low-power, low-cost processor designed for low-end to mid-range applications in the consumer, automotive, industrial, and communications markets where very low power consumption constitutes an important factor. The following are the major features of the MC146805F2 MCU.

Hardware Features

- Typical Full Speed Operating Power of 20 mW
- Standby Power Modes to Less than 1 mW
- 8-Bit Architecture
- 1080 Bytes of Mask Programmed User ROM
- 64 Bytes of On-Chip RAM
- 16 Bidirectional I/O Lines
- 4 Input Lines
- Internal 8-Bit Timer with Software Programmable 7-Bit Prescaler
- External Timer Input
- Full External and Timer Interrupts
- Master Reset and Power-On Reset
- Self-Check Mode
- Single 3- to 6-Volt Supply
- On-Chip Oscillator with Crystal or RC Mask Options
- 28 Pin Dual-In-Line Package
- Chip Carrier Also Available

Software Features

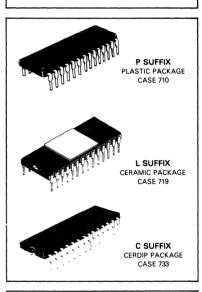
- Similar to the MC6800
- Efficient Use of Program Space
- Versatile Interrupt Handling
- True Bit Manipulation
- Ten Addressing Modes With Indexed Addressing for Tables
- Efficient Instruction Set
- Memory Mapped I/O
- Two Power Saving Standby Modes
- Some Self-Check Routines User Callable

PROGRAMMING MODEL Α Accumulator Х Index Register PC Program Counter 5 4 0 0 0 0 1 1 SP Stack Pointer NZ Condition Code Register Carry/Borrow Zero Negative Interrupt Mask Half Carry

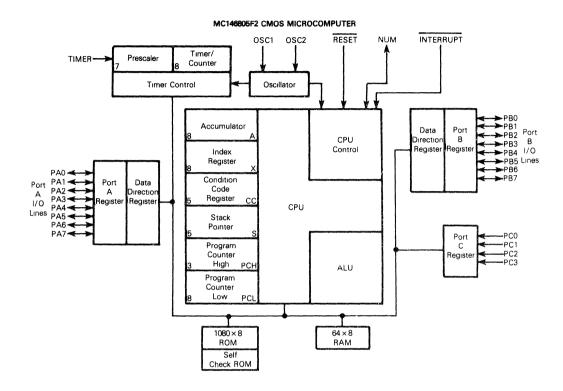
CMOS

(HIGH-PERFORMANCE SILICON-GATE)

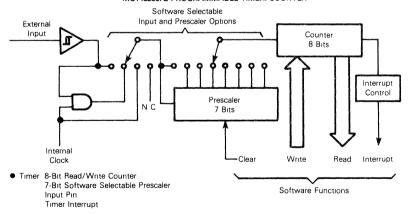
8-BIT MICROCOMPUTER



PIN ASSIGNMENTS RESET 1 28 VDD 27 TIMER IRO 2 26 PC0 NUM 3 oscid 4 25 PC1 24 PC2 OSC2[5 23 PC3 PA0**[**6 22 PB0 PA1**[** 7 21 PB1 PA2[8 20 PB2 PA3 □ 9 19 ДРВЗ 18 DPB4 17 PB5 16 PB6 15 PB7



MC146805F2 PROGRAMMABLE TIMER/COUNTER





MC146805G2

Advance Information

8-BIT MICROCOMPUTER UNIT

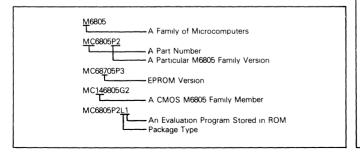
The MC146805G2 Microcomputer Unit (MCU) belongs to the M6805 Family of Microcomputers. This 8-bit MCU contains on-chip oscillator CPU, RAM, ROM, I/O, and Timer. The fully static design allows operation at frequencies down to DC, further reducing its already low-power consumption. It is a low-power processor designed for low-end to midrange applications in the consumer, automotive, industrial, and communications markets where very low power consumption constitutes an important factor. The following are the major features of the MC146805G2 MCU.

Hardware Features

- Typical Full Speed Operating Power of 15 mW at 5 V
- Typical WAIT Mode Power of 4 mW
- Typical STOP Mode Power of 25 μW
- Fully Static Operation
- 112 Bytes of On-Chip RAM
- 2106 Bytes of On-Chip ROM
- 32 Bidirectional I/O Lines
- High Current Drive
- Internal 8-Bit Timer with Software Programmable 7-Bit Prescaler
- External Timer Input
- External and Timer Interrupts
- Self-Check Mode
- Master Reset and Power-On Reset
- Single 3 to 6 Volt Supply
- On-Chip Oscillator with RC or Crystal Mask Options
- 40-Pin Dual-In-Line Package
- Chip-Carrier Also Available

Software Features

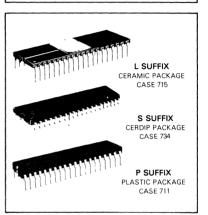
- Similar to the MC6800
- Efficient Use of Program Space
- Versatile Interrupt Handling
- True Bit Manipulation
- Addressing Modes With Indexed Addressing for Tables
- Efficient Instruction Set
- Memory Mapped I/O
- Most Self-Check Routines User Callable
- Two Power Saving Standby Modes

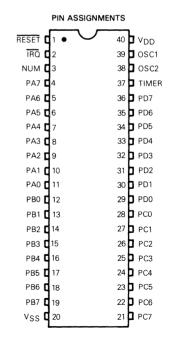


CMOS

(HIGH-PERFORMANCE SILICON-GATE)

8-BIT MICROCOMPUTER





MAXIMUM RATINGS (Voltages Referenced to VSS)

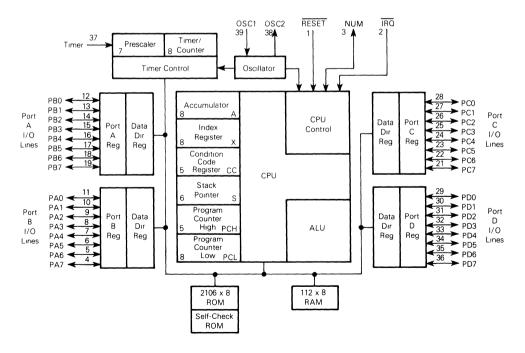
| Ratings | Symbol | Value | Unit |
|---|------------------|--|------|
| Supply Voltage | VDD | -03 to +80 | V |
| All Input Voltages Except OSC1 | V _{ID} | V _{SS} -05 to V _{DD} +05 | V |
| Current Drain Per Pin Excluding VDD and VSS | 1 | 10 | mΑ |
| Operating Temperature Range | TA | 0 to +70 | °C |
| Storage Temperature Range | T _{stq} | -55 to +150 | °C |
| Current Drain Total (PD4-PD7 only) | ЮН | 40 | mA |

THERMAL CHARACTERISTICS

| Characteristics | Symbol | Value | Unit |
|--|--------|------------------------|------|
| Thermal Resistance Plastic Cerdip Ceramic Chip Carrier | hetaJA | 100 60 50 TBD | °C/W |

This device contains circuitry to protect the inputs against damage due to high static voltages of electric fields; however, it is advised that normal precautions be taken to avoid application of any voltage higher than maximum rated voltages to this high impedance circuit. For proper operation it is recommended that V_{in} and V_{out} be constrained to the range $V_{SS} \leq (V_{in})$ or $V_{out}) \leq V_{DD}$ Reliability of operation is enhanced if unused inputs except OSC2 and NUM are tied to an appropriate logic voltage level (e.g., either V_{SS} or V_{DD}).

FIGURE 1 - MC146805G2 CMOS MICROCOMPUTER



DC ELECTRICAL CHARACTERISTICS (See Note 2) ($V_{DD} = 5.0 \text{ Vdc} \pm 10\%$, $V_{SS} = 0 \text{ Vdc}$, $T_A = 0^{\circ}$ to 70° C unless otherwise noted)

| Characteristics | Symbol | Min | Max | Unit |
|--|------------------|----------------------|------|------|
| Output Voltage I _{Load} ≤10.0 μA | V _{OL} | | 0 1 | V |
| | VoH | V _{DD} -01 | | ٧ |
| Output High Voltage | | | | |
| (I _{Load} = -100 μA) PB0-PB7, PC0-PC7 | Voн | 2 4 | - | V |
| (I _{Load} = -2 mA) PA0-PA7 | Voн | 2 4 | _ | ٧ |
| (I _{Load} = -8 mA) PD4-PD7 | Voн | 2 4 | | V |
| Output Low Voltage (I _{Load} =800 µA) All Ports PA0-PA7, PB0-PB7, PC0-PC7, PD0-PD7 | V _{OL} | - | 0 4 | V |
| Input High Voltage Ports PA0-PA7, PB0-PB7, PC0-PC7, PD0-PD7 | ViH | V _{DD} - 20 | _ | ٧ |
| TIMER, IRQ, RESET | ViH | V _{DD} - 08 | _ | V |
| OSC1 | V _{IH} | V _{DD} - 15 | - | V |
| Input Low Voltage All Inputs | V _{IL} | _ | 0.8 | V |
| Total Supply Current ($C_L = 50 \text{ pF}$ on Ports, no DC Loads, $t_{CYC} = 1 \mu s$) RUN (measured during self-check, | | | | |
| $V_{IL} = 0.2 \text{ V}, V_{IH} = V_{DD} - 0.2 \text{ V}$ | IDD | - | 6 | mA |
| WAIT (See Note 1) | ^I DD | | 3 | mA |
| STOP (See Note 1) | סס ^ו | _ | 250 | μΑ |
| I/O Ports Input Leakage PA0-PA7, PB0- PB7, PC0-PC7, PD0-PD7 | IIL | | ± 10 | μΑ |
| Input Current RESET, IRO, TIMER, OSC1 | l _{in} | _ | ±1 | μΑ |
| Capacitance Ports | C _{out} | _ | 12 | pF |
| RESET, IRQ, TIMER, OSC1 | C _{in} | | 8 | pF |

NOTES 1 Test conditions for I_{DD} are as follows
All ports programmed as inputs
VI_L = 0.2 V (PA0-PA7, PB0-PB7, PC0-PC7, PD0-PD7)
VI_H = V_{DD} - 0.2 V for RESET, IRO, TIMER
OSC1 input is a squarewave from 0.2 V to V_{DD} - 0.2 V
OSC2 output load = 20 pF (wait I_{DD} is affected linearly by the OSC2 capacitance)

2. Electrical Characteristics for V_{DD} = 3 V available soon

TABLE 1 - CONTROL TIMING $(V_{DD} = 5.0 \text{ Vdc} \pm 10\%, V_{SS} = 0, T_A = 0^{\circ} \text{ to } 70^{\circ}\text{C}, f_{OSC} = 4 \text{ MHz})$

| Characteristics | Symbol | Min | Max | Unit |
|--|----------|------|-----|------------------|
| Crystal Oscillator Startup Time (Figure 5) | toxov | - | 100 | ms |
| Stop Recovery Startup Time (Crystal Oscillator) (Figure 6) | tILCH | _ | 100 | ms |
| Timer Pulse Width (Figure 4) | tTH, tTL | 05 | | tcyc |
| Reset Pulse Width (Figure 5) | tRL | 1 05 | _ | tcyc |
| Timer Period (Figure 4) | tTLTL | 10 | - | tcyc |
| Interrupt Pulse Width Low (Figure 14) | tilih | 10 | - | tcyc |
| Interrupt Pulse Period (Figure 14) | tILIL | * | | t _{cyc} |
| OSC1 Pulse Width | toh, tol | 100 | | ns |
| Cycle Time | tcyc | 1000 | _ | ns |
| Frequency of Operation | 1 . | | | |
| Crystal | fosc | | 4 0 | MHz |
| External Clock | fosc | DC | 4 0 | MHz |

^{*}The minimum period till should not be less than the number of t_{CYC} cycles it takes to execute the interrupt serioce routines plus 20 t_{CYC} cycles

FIGURE 2 - EQUIVALENT TEST LOAD

| Port | R ₁ | R ₂ |
|------------|----------------|----------------|
| B and C | 24.3 kΩ | 4.32 kΩ |
| A, PD0-PD3 | 1.21 kΩ | 3.1 kΩ |
| PD4-PD7 | 249 ₪ | 1.4 kΩ |

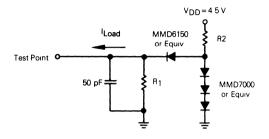
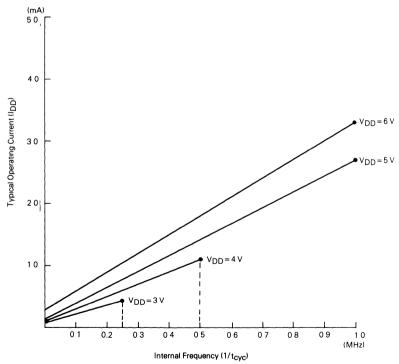
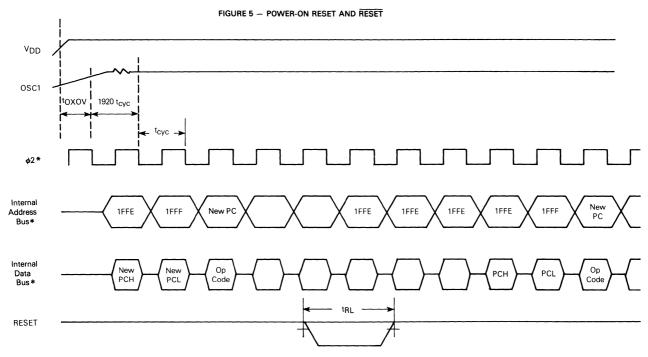


FIGURE 3 - TYPICAL OPERATING CURRENT vs INTERNAL FREQUENCY

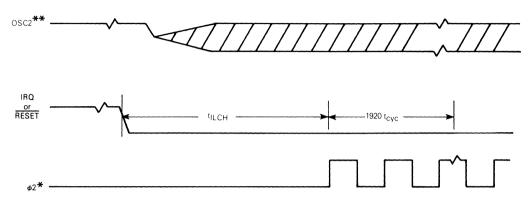




^{*} Internal timing signal not available externally

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FIGURE 6 - STOP RECOVERY AND POWER-ON RESET



- * Internal timing signals not available externally
- ** Represents the internal gating of the OSC1 input pin

FUNCTIONAL PIN DESCRIPTION

V_{DD} and V_{SS}

Power is supplied to the MCU using these two pins VDD is power and VSS is ground

IRQ (MASKABLE INTERRUPT REQUEST)

 \overline{IRQ} is mask option selectable with the choice of interrupt sensitivity being both level and negative-edge or negative-edge only. The MCU completes the current instruction before it responds to the request. If \overline{IRQ} is low and the interrupt mask bit (I-bit) in the Condition Code Register is clear, the MCU begins an interrupt sequence at the end of the current instruction.

If the $\underline{\text{mask}}$ option is selected to include level sensitivity, then the $\overline{\text{IRO}}$ input requires an external resistor to V_{DD} for "wire-OR" operation. (See INTERRUPT section for more detail)

RESET

The RESET input is not required for start-up but can be used to reset the MCU's internal state and provide an orderly software start-up procedure. Refer to the RESET section for a detailed description.

TIMER

The TIMER input may be used as an external clock for the on-chip timer. Refer to TIMER section for a detailed description.

NUM - NON-USER MODE

This pin is intended for use in self-check only. User applications should leave this pin connected to ground through a 10 k resistor.

OSC1, OSC2

The MC146805G2 can be configured to accept either a crystal input or an RC network. Additionally, the internal clocks can be derived by either a divide-by-two or divide-by-four of the external frequency (fosc). Both of these options are mask selectable.

RC- If the RC oscillator option is selected, then a resistor is connected to the oscillator pins as shown in Figure 7b. The relationship between R and $f_{\mbox{\scriptsize OSC}}$ is shown in Figure 8

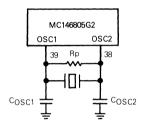
CRYSTAL — The circuit shown in Figure 7(a) is recommended when using a crystal. The internal oscillator is designed to interface with a AT-cut parallel resonant quartz crystal resonator in the frequency range specified for fOSC in the electrical characteristics table. Using an external CMOS oscillator is suggested when crystals outside the specified ranges are to be used. The crystal and components should be mounted as close as possible to the input pins of minimize output distortion and start-up stablization time. Crystal frequency limits are also affected by VDD. Refer to Control Timing Characteristics for limits. See Table 1.

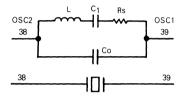
EXTERNAL CLOCK — An external clock should be applied to the OSC1 input with the OSC2 input not connected, as shown in Figure 7(c). An external clock may be used with either the RC or Crystal oscillator mask option. tOXOV or tILCH do not apply when using an external clock input.

FIGURE 7 - OSCILLATOR CONNECTIONS

| | 1 MHz | 4 MHz | Units |
|-------------------|-------|-------|-------|
| RSMAX \ | 400 | 75 | Ω |
| C _O | 5 | 7 | pF |
| C ₁ | 0 008 | 0 012 | μF |
| C _{OSC1} | 15-40 | 15-30 | pF |
| C _{OSC2} | 15-30 | 15-25 | pF |
| Rp | 10 | 10 | MΩ |
| Q | 30 | 40 | _ |

Crystal Parameters

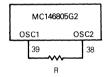


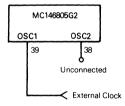


Crystal Oscillator Connections

(a)

Equivalent Crystal Circuit





(b) RC Oscillator Connection

(c) External Clock Source Connections

FIGURE 8 — FREQUENCY vs RESISTANCE FOR RC OSCILLATOR OPTION ONLY

THE TRANSPORT OF THE TRANSPORT OF THE TRANSPORT OF THE TRANSPORT OF THE TRANSPORT OF THE TRANSPORT OF THE TRANSPORT OF THE TRANSPORT OF THE TRANSPORT OF T

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R (kΩ)

PAO-PA7

These eight I/O lines comprise Port A The state of any pin is software programmable. Refer to Input/Output Programming section for a detailed description.

PRO-PR7

These eight lines comprise Port B. The state of any pin is software programmable. Refer to Input/Output Programming section for a detailed description.

PC0-PC7

These eight lines comprise Port C. The state of any pin is software programmable. Refer to the Input/Output Programming section for a detailed description.

PD0-PD7

These eight lines comprise Port D PD4-PD7 also are capable of driving LED's directly. The state of any pin is software programmable. Refer to the Input/Output Programing section for a detailed description.

INPUT/OUTPUT PROGRAMMING

Any port pin may be software programmed as an input or output by the state of the corresponding bit in the port Data Direction Register (DDR). A pin is configured as an output if its corresponding DDR bit is set to a logic '1' A pin is configured as an input if its corresponding DDR bit is cleared to a logic '0'. At reset, all DDRs are cleared, which configures all port pins as inputs. A port pin configured as an output will output the data in the corresponding bit of its port data latch. Refer to Figure 9 and Table 2

FIGURE 9 - TYPCIAL PORT I/O CIRCUITRY

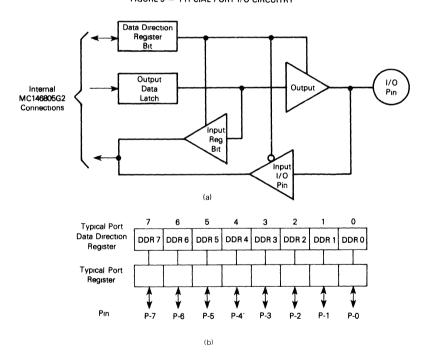


TABLE 2 - I/O PIN FUNCTIONS

| R/W | DDR | I/O Pin Function | | | |
|-----|-----|--|--|--|--|
| 0 | 0 | The I/O pin is in input mode. Data is written into the output data latch | | | |
| 0 | 1 | Data is written into the output data latch and output to the I/O pin | | | |
| 1 | 0 | he state of the I/O pin is read | | | |
| 1 | 1 | The I/O pin is in an output mode. The output data latch is read. | | | |

SELF-CHECK

The MC146805G2 self-check is performed using the circuit in Figure 10. Self-check is initiated by tyring NUM and TIMER pins to a logic 1 then executing a reset. After reset, five subroutines are called that execute the following tests

I/O-Functionally exercise port A, B, C, D

RAM-Walking bit test

ROM - Exclusive OR with odd 1's parity result

Timer - Functionally exercise timer

Interrupts – Functionally exercise external and timer inter-

Self-check results are shown in Table 3. The following subroutines are available to user programs and do not require any external hardware.

RAM SELF-CHECK SUBROUTINE

Returns with the Z-bit clear if any error is detected, otherwise the Z-bit is set

The RAM test must be called with the stack pointer at \$07F. When run, the test checks every RAM cell except for \$07F and \$07E which are assumed to contain the return address

A and X are modified All RAM locations except the top 2 are modified (Enter at location \$1F87)

ROM CHECKSUM SUBROUTINE

Returns with Z-bit cleared if any was found, otherwise Z=1, X=0 on return, and A is zero if the test passed RAM locations \$040-\$043 are overwritten (Enter at location 1FA1)

TIMER TEST SUBROUTINE

Return with Z-bit cleared if any error was found, otherwise Z=1

This routine runs a simple test on the timer. In order to work correctly as a user subroutine, the internal clock must be the clocking source and interrupts must be disabled Also, on exit, the clock will be running and the interrupt mask not set so the caller must protect himself from interrupts if necessary

A and X register contents are lost, this routine counts how many times the clock counts in 128 cycles. The number of counts should be a power of two since the prescaler is a power of two. If not, the timer probably is not counting correctly. The routine also detects if the timer is running at all (Enter at location \$1FBB.)

MEMORY

The MC146805G2 has a total address space of 8192 bytes of memory and I/O registers. The address space is shown in Figure 11.

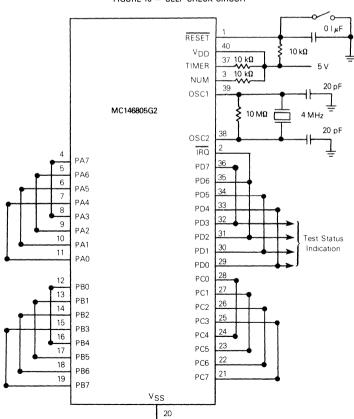
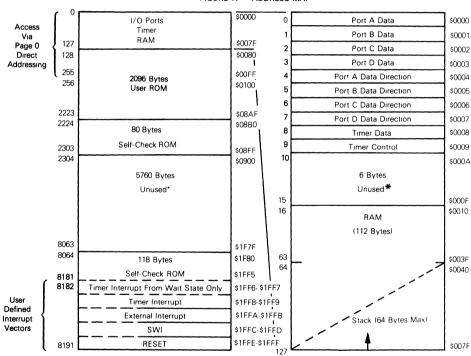


FIGURE 10 - SELF-CHECK CIRCUIT

TABLE 3 - SELF-CHECK RESULTS

| PD3 | PD2 | PD1 | PD0 | Remarks |
|-----|-------|--------|-----|-------------------------------|
| 1 | 0 | 1 | 0 | Bad I/O |
| 1 | 0 | 1 | 1 | Bad Timer |
| 1 | 1 | 0 | 0 | Bad RAM |
| 1 | 1 | 0 | 1 | Bad ROM |
| 1 | 1 | 1 1 | | Bad Interrupt or Request Flag |
| 1 | All C | ycling | | Good Part |
| | All O | thers | | Bad Part |

FIGURE 11 - ADDRESS MAP



[★]Reads of unused locations undefined

The first 128 bytes of memory (first half of page zero) is comprised of the I/O port locations, timer locations, and 112 bytes of RAM. The next 2096 bytes comprise the user ROM. The 10 highest address bytes contain the reset and interrupt vectors.

The stack pointer is used to address data stored on the stack Data is stored on the stack during interrupts and subroutine calls. At power-up, the stack pointer is set to \$007F and it is decremented as data is pushed on the stack. When data is removed from the stack, the stack pointer is incremented. A maximum of 64 bytes of RAM is available for stack usage. Since most programs use only a small part of the allocated stack locations for interrupts and/or subroutine stacking purposes, the unused bytes are usable for program data storage.

REGISTERS

The MC146805G2 contains five registers as shown in the programming model in Figure 12. The interrupt stacking order is shown in Figure 13.

ACCUMULATOR (A)

This accumulator is an 8-bit general purpose register used for arithmetic calculations and data manipulations

INDEX REGISTER (X)

The X register is an 8-bit register which is used during the indexed modes of addressing. It provides an 8-bit operand which is used to create an effective address. The index register is also used for data manipulations with the read/modify/write type of instructions and as a temporary storage register when not performing addressing operations.

PROGRAM COUNTER (PC)

The program counter is a 13-bit register that contains the address of the next instruction to be executed by the processor

STACK POINTER (SP)

The stack pointer is a 13-bit register containing the address of the next free location on the stack. When accessing memory, the seven most-significant bits are permanently set to 0000001. These seven bits are appended to the six least-significant register bits to produce an address within the range of \$007F to \$0040. The stack area of RAM is used to store the return address on subroutine calls and the

FIGURE 12 - PROGRAMMING MODEL

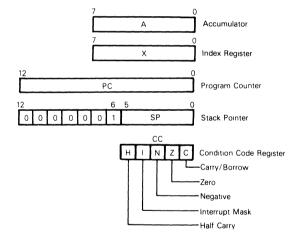
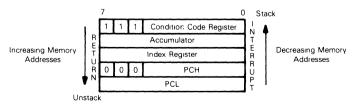


FIGURE 13 - STACKING ORDER



NOTE Since the Stack Pointer decrements during pushes, the PCL is stacked first, followed by PCH, etc. Pulling from the stack is in the reverse order.

machine state during interrupts. During external or poweron reset, and during a "reset stack pointer" instruction, the stack pointer is set to its upper limit (\$007F). Nested interrupts and/or subroutines may use up to 64 (decimal) locations, beyond which the stack pointer "wraps around" and points to its upper limit thereby losing the previously stored information. A subroutine call occupies two RAM bytes on the stack, while an interrupt uses five bytes.

CONDITION CODE REGISTER (CC)

The condition code register is a 5-bit register which indicates the results of the instruction just executed. These bits can be individually tested by a program and specific action taken as a result of their state. Each bit is explained in the following paragraphs.

HALF CARRY BITS (H) — The H-bit is set to a one when a carry occurs between bits 3 and 4 of the ALU during an ADD or ADC instruction. The H-bit is useful in binary coded decimal subroutines.

INTERRUPT MASK BIT (I) — When the I-bit is set, both the external interrupt and the timer interrupt are disabled Clearing this bit enables the above interrupts. If an interrupt occurs while the I-bit is set, the interrupt is latched and is processed when the I-bit is next cleared.

NEGATIVE (N) — Indicates that the result of the last arithmetic, logical, or data manipulation is negative (bit 7 in the result is a logical one)

ZERO (Z) — Indicates that the result of the last arithmetic, logical, or data manipulation is zero

CARRY/BORROW (C) — Indicates that a carry or borrow out of the arithmetic logic unit (ALU) occurred during the last arithmetic operation. This bit is also affected during bit test and branch instructions, shifts, and rotates

RESETS

The MC146805G2 has two reset modes an active low external reset pin (\overline{RESET}) and a power-on reset function, refer to Figure 5

RESET

The RESET input pin is used to reset the MCU to provide an orderly software start-up procedure. When using the external reset mode, the RESET pin must stay low for a minimum of one t_{CyC}. The RESET pin is provided with a Schmitt Trigger input to improve its noise immunity.

POWER-ON RESET

The power-on reset occurs when a positive transition is detected on Vpp. The power-on reset is used strictly for power turn-on conditions and should not be used to detect any drops in the power supply voltage. There is no provision for a power-down reset The power-on circuitry provides for a 1920 t_{CVC} delay from the time of the first oscillator operation If the external RESET pin is low at the end of the 1920 t_{CVC} time out, the processor remains in the reset condition.

Either of the two types of reset conditions causes the following to occur

- -- Timer control register interrupt request bit TCR7 is cleared to a "0"
- Timer control register interrupt mask bit TCR6 is set to a
- All data direction register bits are cleared to a "0" All ports are defined as inputs
- Stack pointer is set to \$007F
- The internal address bus is forced to the reset vector (\$1FFE, \$1FFF)
- Condition code register interrupt mask bit (I) is set to a
 "1"
- STOP and WAIT latches are reset
- External interrupt latch is reset

All other functions, such as other registers (including output ports), the timer, etc., are not cleared by the reset conditions.

INTERRUPTS

The MC146805G2 is capable of operation with three different interrupts, two hardware (timer interrupt and external interrupt), and one software (SWI). When any of these interrupts occur, normal processing is suspended at the end of the current instruction execution. All of the program registers (the machine state) are pushed onto the stack, refer to Figure 13 for stacking order. The appropriate vector pointing to the starting address of the interrupt service routine is then fetched, refer to Figure 14 for the interrupt sequence.

The priority of the various interrupts from highest to lowest is as follows

RESET →* → External Interrupt → Timer Interrupt

TIMER INTERRUPT

If the timer mask bit (TCR6) is cleared, then each time the timer decrements to zero (transitions from \$01 to \$00) an interrupt request is generated. The actual processor interrupt is generated only if the interrupt mask bit of the condition code register is also cleared. When the interrupt is recognized, the current state of the machine is pushed onto the stack and the interrupt mask bit in the condition code register is set. This masks further interrupts until the present one is serviced The processor now vectors to the timer interrupt service routine. The address for this service routine is specified by the contents of \$1FF8 and \$1FF9 unless the processor is in a WAIT mode in which case the contents of \$1FF6 and \$1FF7 specify the timer service routine address. Software must be used to clear the timer interrupt request bit (TCR7). At the end of the timer interrupt service routine, the software normally executes an RTI instruction which restores the machine state and starts executing the interrupted program.

EXTERNAL INTERRUPT

If the interrupt mask bit of the condition code register is cleared and the external interrupt pin is "low," then the external interrupt occurs. The action of the external interrupt is

^{*}Any current instruction including SWI

Execute Instruction Instruction No Complete Interrupt No Mask = 0Yes Yes No External No TCR Interrupt? Bit 6=07 Yes Yes Interrupt No No TCR Mask = 0? Bit 7 = 1? Yes Yes Force Interrupt Execution, Set Force Interrupt Interrupt Mask, Execution, Set Fetch Ext Int Interrupt Mask, Vector, Reset Fetch Timer Interrupt Latch Vector *Note Interrupt Sequence No Complete? Yes Load Next Instruction

FIGURE 14 — INTERRUPT AND INSTRUCTION PROCESSING FLOWCHART

^{*}NOTE The clear of TCR bit 7 must be accomplished with software

identical to the timer interrupt with the exception that the service routine address is specified by the contents of \$1FFA and \$1FFB Either a level- and edge-sensitive (or edge-sensitive only) are available as mask options Figure 15 shows both a functional diagram and timing for the interrupt line The timing diagram shows two different treatments of the interrupt line (IRQ) to the processor. The first method is single pulses on the interrupt line spaced far enough apart to be serviced. The minimum time between pulses is a function of the length of the interrupt service routine. Once a pulse occurs, the next pulse should not occur until the MPU software has exited the routine (an RTI occurs). This time (til II) is obtained by adding 20 instruction cycles (t_{CyC}) to the total number of cycles it takes to complete the service routine including the RTI instruction, refer to Figure 15. The second configuration shows many interrupt lines "wire ORed" to form the interrupts at the processor. Thus, if after servicing an interrupt the IRO remains low, then the next interrupt is recognized

SOFTWARE INTERRUPT (SWI)

The software interrupt is an executable instruction. The action of the SWI instruction is similar to the hardware interrupts. The SWI is executed regardless of the state of the interrupt mask in the condition code register. The service routin address is specified by the contents of memory locations \$1FFC and \$1FFD. See Figure 14 for interrupt and instruction processing flowchart.

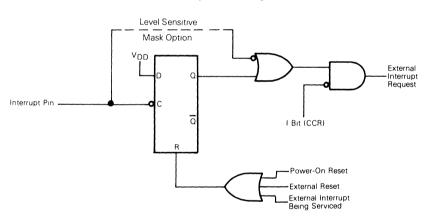
The following three functions are not strictly interrupts, however, they are tied very closely to the interrupts. These functions are RESET, STOP, WAIT

RESET

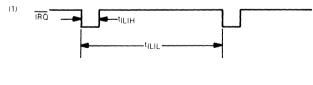
The RESET input pin and the internal power-on reset function each cause the program to vector to an initialization program. This vector is specified by the contents of memory locations \$1FFE and \$1FFF. The interrupt mask of the condition code register is also set. Refer to Resets section for details.

FIGURE 15 - EXTERNAL INTERRUPT

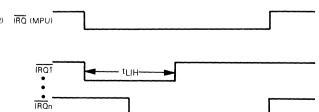
(a) Interrupt Functional Diagram



(b) Interrupt Mode Diagram



Edge Condition (The minimum pulse width (t_{ILIH} is one t_{CyC} . The period t_{ILIL} should not be less than the number of t_{CyC} cycles it takes to execute the interrupt service routine plus 20 t_{CyC} cycles)



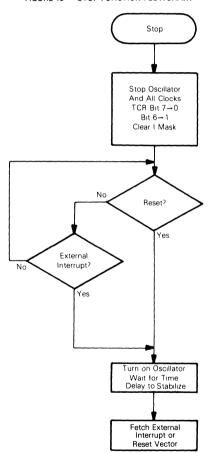
Mask Optional Level Sensitive (If after servicing an interrupt the \overline{IRO} remains low, then the next interrupt is recognized)

STOP

The STOP instruction places the MC146805G2 in its lowest power consumption mode. In the STOP function the internal oscillator is turned off, causing all internal processing and the timer to be halted, refer to Figure 16.

During the STOP mode, timer control register (TCR) bits 6 and 7 are altered to remove any pending timer interrupt requests and to disable any further timer interrupts. The timer prescaler is cleared. External interrupts are enabled in the condition code register. All other registers and memory remain unaltered. All I/O lines remain unchanged.

FIGURE 16 - STOP FUNCTION FLOWCHART



WAIT

The WAIT instruction places the MC146805G2 in a low power consumption mode, but the WAIT mode consumes somewhat more power than the STOP mode. In the WAIT mode, the internal clock is disabled from all internal circuitry

except the timer circuit; refer to Figure 17. Thus, all internal processing is halted, however, the timer continues to count normally.

During the Wait mode, the I-bit in the condition code register is cleared to enable interrupts. All other registers, memory, and I/O lines remain in their last state. The timer may be enabled to allow a periodic exit from the Wait mode If an external and a timer interrupt occur at the same time, the external interrupt is serviced first, then, if the timer interrupt request is not cleared in the external interrupt routine, the normal timer interrupt (not the timer Wait interrupt) is serviced since the MCU is no longer in the WAIT mode.

TIMER

The MCU timer contains a 8-bit software programmable counter with7-bit software selectable prescaler. The counter may be present under program control and decrements towards zero. When the counter decrements to zero, the timer interrupt request bit, i.e., bit 7 of the timer control register (TRC), is set. Then, if the timer interrupt is not masked, i.e., bit 6 of the TCR and the I-bit in the condition code register are both cleared, the processor receives an interrupt. After completion of the current instruction, the processor proceeds to store the appropriate registers on the stack, and then fetches the timer vector address from locations \$1FF8 and \$1FF9 (or \$1FF6 and \$1FF7 if in the WAIT mode) in order to beging servicing

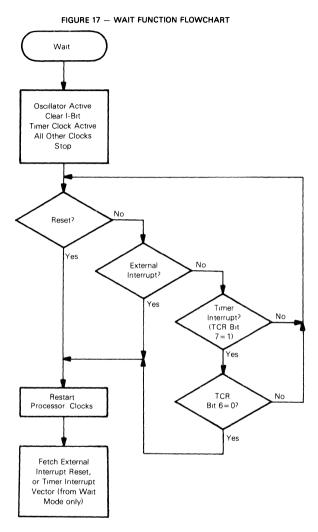
The counter continues to count after it reaches zero, allowing the software to determine the number of internal or external input clocks since the timer interrupt request bit was set. The counter may be read at any time by the processor without disturbing the count. The contents of the counter becomes stable prior to the read portion of a cycle and does not change during the read. The timer interrupt request bit remains set until cleared by the software. If a read occurs before the timer interrupt is serviced, the interrupt is lost TCR7 may also be used as a scanned status bit in a non-interrupt mode of operation (TCR6=1)

The prescaler is a 7-bit divider which is used to extend the maximum length of the timer Bit 0, bit 1 and bit 2 of the TCR are programmed to choose the appropriate prescaler output which is used as the counter input. The processor cannot write into or read from the prescaler, however, its contents are cleared to all "O's" by the write operation into TCR when bit 3 of the written data equals 1. This allows for truncation-free counting.

The timer input can be configured for three different operating modes, plus a disable mode depending on the value written to the TCR4, TCR5 control bits. Refer to the Timer Control Register section.

TIMER INPUT MODE 1

If TCR4 and TCR5 are both programmed to a "0," the input to the timer is from an internal clock and the TIMER input pin is disabled. The internal clock mode can be used for periodic interrupt generation, as well as a reference in frequency and event measurement. The internal clock is the instruction cycle clock. During a WAIT instruction, the internal clock to the timer continues to run at its normal rate.



TIMER INPUT MODE 2

With TCR4=1 and TCR5=0, the internal clock and the TIMER input pin are ANDed together to form the timer input signal. This mode can be used to measure external pulse widths. The external pulse simply turns on the internal clock for the duration of the pulse. The resolution of the count in this mode is ± 1 clock and, therefore, accuracy improves with longer input pulse widths.

TIMER INPUT MODE 3

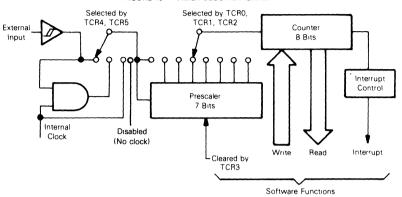
If TCR4=0 and TCR5=1, then all inputs to the Timer are disabled

TIMER INPUT MODE 4

If TCR4=1 and TCR5=1, the internal clock input to the Timer is disabled and the TIMER input pin becomes the input to the Timer. The timer can, in this mode, be used to count external events as well as external frequencies for generating periodic interrupts. The counter is clocked on the falling edge of the external signal.

Figure 18 shows a block diagram of the Timer subsystem Power-on Reset and the STOP instruction cause the counter to be set to \$FO

FIGURE 18 - TIMER BLOCK DIAGRAM



NOTES

- 1 Prescaler and 8-bit counter are clocked on the falling edge of the internal clock or external input
- 2 Counter counts down continuously

Timer Control Register (TCR)

| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|------|------|------|------|------|------|------|------|
| TCR7 | TCR6 | TCR5 | TCR4 | TCR3 | TCR2 | TCR1 | TCR0 |

All bits in this register except bit 3 are Read/Write bits

 ${\bf TCR7}-{\bf Timer}$ interrupt request bit bit used to indicate the timer interrupt when it is logic "1"

- 1 Set whenever the counter decrements to zero, or under program control
- Cleared on external reset, power-on reset, STOP instruction, or program control

 ${\bf TCR6}-{\bf Timer}$ interrupt mask bit when this bit is a logic "1" it inhibits the timer interrupt to the processor

- 1 Set on external reset, power-on reset, STOP instruction, or program control
- 0 Cleared under program control

 $\mbox{TCR5}$ — External or internal bit, selects the input clock source to be either the external timer pin or the internal clock (Unaffected by $\overline{\mbox{RESET}}$)

- 1 Select external clock source
- 0 Select internal clock source (AS)

TCR4 — External enable bit, control bit used to enable the external timer pin (Unaffected by RESET)

- 1 Enable external timer pin.
- 0 Disable external timer pin.

TCR5 TCR4

| 0 | 0 | Internal clock to Timer |
|---|---|--|
| 0 | | AND of internal clock and TIMER pin to Timer |
| 1 | 0 | Inputs to Timer disabled |
| 1 | 1 | TIMER pin to Timer |

Refer to Figure 18 for Logic Representation

TCR3 — Timer Prescaler Reset bit writing a "1" to this bit resets the prescaler to zero. A read of this location always indicates a "0". (Unaffected by RESET.)

TCR2, TCR1, TCR0 — Prescaler select bits decoded to select one of eight taps on the prescaler (Unaffected by $\overline{\text{RESET}}$)

Prescaler

| TCR2 | TCR1 | TCR0 | Result |
|------|------|------|--------|
| 0 | 0 | 0 | -1 |
| 0 | 0 | 1 | -2 |
| 0 | 1 | 0 | -4 |
| 0 | 1 | 1 | -8 |
| 1 | 0 | 0 | - 16 |
| 1 | 0 | 1 | - 32 |
| 1 | 1 | 0 | - 64 |
| 1 | 1 | 1 | - 128 |

INSTRUCTION SET

The MCU has a set of 61 basic instructions. They can be divided into five different types: register/memory, read/modify/write, branch, bit manipulation, and control. The following paragraphs briefly explain each type. All the instructions within a given type are presented in individual tables.

REGISTER/MEMORY INSTRUCTIONS

Most of these instructions use two operands. One operand is either the accumulator or the index register. The other operand is obtained from memory using one of the addressing modes. The operand for the jump unconditional (JMP) and jump to subroutine (JSR) instructions are the program counter. Refer to Table 4.

READ/MODIFY/WRITE INSTRUCTIONS

These instructions read a memory location or a register, modify or test its contents, and write the modified value back to memory or to the register. The test for negative or zero (TST) instruction is an exception to the read/modify/write sequence since it does not modify the value. Refer to Table 5.

BRANCH INSTRUCTIONS

Most branch instructions test the state of the Condition Code Register and if certain criteria are met, a branch is executed. This adds an offset between + 128 and - 127 to the current program counter. Refer to Table 6.

BIT MANIPULATION INSTRUCTIONS

The MPU is capable of setting or clearing any bit which resides in the first 256 bytes of the memory space, where all port registers, port DDR's, timer, timer control, and on-chip RAM reside. An additional feature allows the software to test and branch on the state of any bit within these 256 locations. The bit set, bit clear and bit test and branch functions are all implemented with a single instruction. For the test and branch instructions the value of the bit tested is also placed in the carry bit of the Condition Code Register. Refer to Table 7 for instruction cycle timing.

CONTROL INSTRUCTIONS

These instructions are register reference instructions and are used to control processor operation during program execution. Refer to Table 8 for instruction cycle timing.

ALPHABETICAL LISTING

The complete instruction set is given in alphabetical order in Table 10.

OPCODE MAP

Table 9 is an opcode map for the instructions used on the MCU.

ADDRESSING MODES

The MCU uses ten different addressing modes to give the programmer an opportunity to optimize the code to all situations. The various indexed addressing modes make it possible to locate data tables, code conversion tables and scalling tables anywhere in the memory space. Short indexed accesses are single byte instructions, while the longest instructions (three bytes) permit tables throughout memory. Short

and long absolute addressing is also included. One and two byte direct addressing instructions access all data bytes inmost applications. Extended addressing permits jump instructions to reach all memory. Table 10 shows the addressing modes for each instruction, with the effects each instruction has on the Condition Code Register. An opcode map is shown in Table 9.

The term "Effective Address" (EA) is used in describing the various addressing modes, which is defined as the byte address to or from which the argument for an instruction is fetched or stored. The ten addressing modes of the processor are described below. Parentheses are used to indicate "contents of," an arrow indicates "is replaced by" and a colon indicates concatenation of two bytes. For additional details and graphical illustrations, refer to the M6805 Family User Manual.

INHERENT

In inherent instructions all the information necessary to execute the instruction is contained in the opcode. Operations specifying only the index register or accumulator, and no other arguments, are included in this mode.

IMMEDIATE

In immediate addressing, the operand is contained in the byte immediately following the opcode. Immediate addressing is used to access constants which do not change during program execution (e.g., a constant used to initialize a loop counter).

$$EA = PC + 1$$
, $PC \leftarrow PC + 2$

DIRECT

In the direct addressing mode, the effective address of the argument is contained in a signle byte following the opcode byte. Direct addressing allows the user to directly address the lowest 256 bytes in memory with a single two byte instruction. This includes all on-chip RAM and I/O registers and 128 bytes of on-chip ROM. Direct addressing is efficient in both memory and time.

EA =
$$(PC+1)$$
, $PC-PC+2$
Address Bus High-0, Address Bus Low- $(PC+1)$

In the extended addressing mode, the effective address of the argument is contained in the two bytes following the opcode. Instructions with extended addressing modes are capable of referencing arguments anywhere in memory with a single thre byte instruction. When using the Motorola assembler, the user need not specify whether an instruction uses direct or extended addressing. The assembler automatically selects the most efficient addressing mode.

 $EA = (PC + 1).(PC + 2); PC \leftarrow PC + 3$ Address Bus High \(\therefore\) (PC + 1); Address Bus Low \(\therefore\) (PC + 2)

INDEXED, NO-OFFSET

In the indexed, no offset addressing mode, the effective address of the argument is contained in the 8-bit index register. Thus, this addressing mode can access the first 256 memory locations. These instructions are only one byte long and therefore are more efficient. This mode is used to move a pointer through a table or to address a frequency referenced RAM or I/O location.

EA = X; $PC \leftarrow PC + 1$ Address Bus High $\leftarrow 0$; Address Bus Low $\leftarrow X$

INDEXED, 8-BIT OFFSET

Here the EA is obtained by adding the contents of the byte following the opcode to that of the index register. The operad is therefore located anywhere within the lowest 511 memory locations. For example, this mode of addressing is useful for selecting the m-th element in an n element table. All instructions are two bytes. The contents of the index register (X) is not changed. The contents of (PC+1) is an unsigned 8-bit integer. One byte offset indexing permits look-up tables to be easily accessed in either RAM or ROM.

$$EA = + (PC + 1), PC \leftarrow PC + 2$$

Address Bus High \leftarrow K, Address Bus Low \leftarrow X + (PC + 1) Where K = The carry from the addition of X + (PC + 1)

INDEXED, 16-BIT OFFSET

In the indexed, 16-bit offset addressing mode the effective address is the sum of the contents of the unsigned 8-bit index register and the two unsigned bytes following the opcode This addressing mode can be used in a manner similar to indexed 8-bit offset, except that this three byte instruction allows tables to be anywhere in memory (e.g., jump tables in ROM). As with direct and extended, the M6805 assembler determines the most efficient form of indexed offset — 8 or 16 bit. The content of the index register is not changed.

EA =
$$X + [(PC + 1).(PC + 2)]$$
, $PC \leftarrow PC + 3$
Address Bus High $\leftarrow (PC + 1) + K$,
Address Bus Low $\leftarrow X + (PC + 2)$

Where K =The carry from the addition of X + (PC + 2)

RELATIVE

Relative addressing is only used in branch instructions. In relative addressing the contents of the 8-bit signed byte following the opcode (the offset) is added to the PC if and only if the branch condition is true. Otherwise, control proceeds to the next instruction. The span of relative addressing

is limited to the range of -126 to +129 bytes from the branch instruction opcode location. The Motorola assembler calculates the proper offset and checks to see if it is within the span of the branch.

$$EA = PC + 2 + (PC + 1)$$
, $PC \leftarrow EA$ if branch taken,
otherwise $PC \leftarrow PC + 2$

BIT SET/CLEAR

Direct addressing and bit addressing are combined in instructions which set and clear individual memory and I/O bits. In the bit set and clear instructions, the byte is specified as a direct address in the location following the opcode. The first 256 addressable locations are thus accessed. The bit to be modified within that byte is specified with three bits of the opcode. The bit set and clear instructions occupy two bytes, one for the opcode (including the bit number) and the second to address the byte which contains the bit of interest

EA =
$$(PC + 1)$$
, $PC \leftarrow PC + 2$
Address Bus High $\leftarrow 0$, Address Bus Low $\leftarrow (PC + 1)$

BIT TEST AND BRANCH

Bit test and branch is a combination of direct addressing, bit addressing and relative addressing. The bit address and condition (set or clear) to be tested is part of the opcode. The address of the byte to be tested is in the single byte immediately following the opcode byte (EA1). The signed relative 8-bit offset is in the third byte (EA2) and is added to the PC if the specified bit is set or clear in the specified memory location. This single three byte instruction allows the program to branch based on the condition of any bit in the first 256 locations of memory.

EA1 = (PC + 1)
Address Bus High
$$\leftarrow$$
 0, Address Bus Low \leftarrow (PC + 1)
EA2 = PC + 3 + (PC + 2), PC \leftarrow EA2 if branch taken,
otherwise PC \leftarrow PC + 3

TABLE 4 - REGISTER/MEMORY INSTRUCTIONS

| | | | | | | DLL 4 | REGISTI | -11/ ///- | | | | | | | | | | | |
|---|----------|------------|------------|-------------|------------|------------|-------------|------------|------------|------------------------|------------|------------|---------------------------|------------|------------|----------------------------|------------|------------|-------------|
| | | | | | | | | | | Addressir | ng Mode | s | | | | | | | |
| | | 1 | mmediat | е | Direct | | | Extended | | Indexed (No Offset) | | | Indexed (8-Bit Offset) | | | Indexed (16-Bit Offset) | | | |
| Function | Mnemonic | Op Code | # Bytes | # Cycles | Op Code | # Bytes | # Cycles | Op Code | # Bytes | # Cycles | Op Code | # Bytes | # Cycles | Op Code | # Bytes | # Cycles | Op Code | # Bytes | # Cycles |
| Load A from Memory | LDA | A6 | 2 | 2 | B6 | 2 | 3 | C6 | 3 | 4 | F6 | 1 | 3 | E6 | 2 | 4 | D6 | 3 | 5 |
| Load X from Memory | LDX | AE | 2 | 2 | BE | 2 | 3 | CE | 3 | 4 | FE | 1 | 3 | EE | 2 | 4 | DE | 3 | 5 |
| Store A in Memory | STA | _ | _ | _ | B7 | 2 | 4 | C7 | 3 | 5 | F7 | 1 | 4 | E7 | 2 | 5 | D7 | 3 | 6 |
| Store X in Memory | STX | - | - | _ | BF | 2 | 4 | CF | 3 | 5 | FF | 1 | 4 | EF | 2 | 5 | DF | 3 | 6 |
| Add Memory to A | ADD | AB | 2 | 2 | ВВ | 2 | 3 | СВ | 3 | 4 | FB | 1 | 3 | EB | 2 | 4 | DB | 3 | 5 |
| Add Memory and Carry to A | ADC | A9 | 2 | 2 | В9 | 2 | 3 | С9 | 3 | 4 | F9 | 1 | 3 | E9 | 2 | 4 | D9 | 3 | 5 |
| Subtract Memory | SUB | A0 | 2 | 2 | В0 | 2 | 3 | C0 | S | 4 | F0 | 1 | 3 | E0 | 2 | 4 | D0 | 3 | 5 |
| Subtract Memory from A with Borrow | SBC | A2 | 2 | 2 | B2 | 2 | 3 | C2 | 3 | 4 | F2 | 1 | 3 | E2 | 2 | 4 | D2 | 3 | 5 |
| AND Memory to A | AND | A4 | 2 | 2 | B4 | 2 | 3 | C4 | 3 | 4 | F4 | 1 | 3 | E4 | 2 | 4 | D4 | 3 | 5 |
| OR Memory with A | ORA | AA | 2 | 2 | BA | 2 | 3 | CA | 3 | 4 | FA | 1 | 3 | EA | 2 | 4 | DA | 3 | 5 |
| Exclusive OR Memory with A | EOR | A8 | 2 | 2 | В8 | 2 | 3 | C8 | 3 | 4 | F8 | 1 | 3 | E8 | 2 | 4 | D8 | 3 | 5 |
| Arithmetic Compare A with Memory | СМР | Α1 | 2 | 2 | В1 | 2 | 3 | C1 | 3 | 4 | F1 | 1 | 3 | E1 | 2 | 4 | D1 | 3 | 5 |
| Arithmetic Compare X with Memory | CPX | А3 | 2 | 2 | В3 | 2 | 3 | С3 | 3 | 4 | F3 | 1 | 3 | E3 | 2 | 4 | D3 | 3 | 5 |
| Bit Test Memory with A (Logical Compare) | BIT | A5 | 2 | 2 | B5 | 2 | 3 | C5 | 3 | 4 | F5 | 1 | 3 | E5 | 2 | 4 | D5 | 3 | 5 |
| Jump Unconditional | JMP | _ | - | _ | вс | 2 | 2 | СС | 3 | 3 | FC | 1 | 2 | EC | 2 | 3 | DC | 3 | 4 |
| Jump to Subroutine | JSR | _ | _ | _ | BD | 2 | 5 | CD | 3 | 6 | FD | 1 | 5 | ED | 2 | 6 | DD | 3 | 7 |

TABLE 5 - READ/MODIFY/WRITE INSTRUCTIONS

| | | | | | | | | , | Addressii | ng Mode | S | | | | | |
|------------------------------|----------|------------|------------|-------------|------------|------------|-------------|------------|------------|-------------|------------|---------------------|-------------|------------|---------------------|-------------|
| | | In | herent (| A) | lr | herent (| X) | | Direct | | (| Indexed No Offse | | (8 | Indexed Bit Offs | |
| Function | Mnemonic | Op Code | # Bytes | # Cycles | Op Code | # Bytes | # Cycles | Op Code | # Bytes | # Cycles | Op Code | # Bytes | # Cycles | Op Code | # Bytes | # Cycles |
| Increment | INC | 4C | 1 | 3 | 5C | 1 | 3 | 3C | 2 | 5 | 7C | 1 | 5 | 6C | 2 | 6 |
| Decrement | DEC | 4A | 1 | 3 | 5A | 1 | 3 | 3A | 2 | 5 | 7A | 1 | 5 | 6A | 2 | 6 |
| Clear | CLR | 4F | 1 | 3 | 5F | 1 | 3 | , 3F | 2 | 5 | 7F | 1 | 5 | 6F | 2 | 6 |
| Complement | СОМ | 43 | 1 | 3 | 53 | 1 | 3 | 33 | 2 | 5 | 73 | 1 | 5 | 63 | 2 | 6 |
| Negate (2's Complement) | NEG | 40 | 1 | 3 | 50 | 1 | 3 | 30 | 2 | 5 | 70 | 1 | 5 | 60 | 2 | 6 |
| Rotate Left Thru Carry | ROL | 49 | 1 | 3 | 59 | 1 | 3 | 39 | 2 | 5 | 79 | 1 | 5 | 69 | 2 | 6 |
| Rotate Right Thru Carry | ROR | 46 | 1 | 3 | 56 | 1 | 3 | 36 | 2 | 5 | 76 | 1 | 5 | 66 | 2 | 6 |
| Logical Shift Left | LSL | 48 | 1 | 3 | 58 | 1 | 3 | 38 | 2 | 5 | 78 | 1 | 5 | 68 | 2 | 6 |
| Logical Shift Right | LSR | 44 | 1 | 3 | 54 | 1 | 3 | 34 | 2 | 5 | 74 | 1 | 5 | 64 | 2 | 6 |
| Arithmetic Shift Right | ASR | 47 | 1 | 3 | 57 | 1 | 3 | 37 | 2 | 5 | 77 | 1 | 5 | 67 | 2 | 6 |
| Test for Negative or Zero | TST | 4D | 1 | 3 | 5D | 1 | 3 | 3D | 2 | 4 | 7D | 1 | 4 | 6D | 2 | 5 |

TABLE 6 - BRANCH INSTRUCTIONS

| | Relative Addressing Mode | | | | | | | | | |
|--|--------------------------|------------|------------|-------------|--|--|--|--|--|--|
| Function | Mnemonic | Op Code | # Bytes | # Cycles | | | | | | |
| Branch Always | BRA | 20 | 2 | 3 | | | | | | |
| Branch Never | BRN | 21 | 2 | 3 | | | | | | |
| Branch IFF Higher | ВНІ | 22 | 2 | 3 | | | | | | |
| Branch IFF Lower or Same | BLS | 23 | 2 | 3 | | | | | | |
| Branch IFF Carry Clear | BCC | 24 | 2 | 3 | | | | | | |
| (Branch IFF Higher or Same) | (BHS) | 24 | 2 | 3 | | | | | | |
| Branch IFF Carry Set | BCS | 25 | 2 | 3 | | | | | | |
| (Branch IFF Lower) | (BLO) | 25 | 2 | 3 | | | | | | |
| Branch IFF Not Equal | BNE | 26 | 2 | 3 | | | | | | |
| Branch IFF Equal | BEQ | 27 | 2 | 3 | | | | | | |
| Branch IFF Half Carry Clear | BHCC | 28 | 2 | 3 | | | | | | |
| Branch IFF Half Carry Set | BHCS | 29 | 2 | 3 | | | | | | |
| Branch IFF Plus | BPL | 2A | 2 | 3 | | | | | | |
| Branch IFF Minus | BMI | 2B | 2 | 3 | | | | | | |
| Branch IFF Interrupt Mask Bit is Clear | BMC | 2C | 2 | 3 | | | | | | |
| Branch IFF Interrupt Mask Bit is Set | BMS | 2D | 2 | 3 | | | | | | |
| Branch IFF Interrupt Line is Low | BIL | 2E | 2 | 3 | | | | | | |
| Branch IFF Interrupt Line is High | BIH | 2F | 2 | 3 | | | | | | |
| Branch to Subroutine | BSR | AD | 2 | 6 | | | | | | |

TABLE 7 - BIT MANIPULATION INSTRUCTIONS

| | | | | Addre | essing Mod | es | | | | | |
|---------------------------|-------------------|------------|-----------------------------------|-------------|------------|------------|-------------|--|--|--|--|
| | | Bi | Bit Set/Clear Brt Test and Branch | | | | | | | | |
| Function | Mnemonic | Op Code | # Bytes | # Cycles | Op Code | # Bytes | # Cycles | | | | |
| Branch IFF Bit n is Set | BRSET n (n = 0 7) | _ | _ | _ | 2•n | 3 | 5 | | | | |
| Branch IFF Bit n is Clear | BRCLR n (n = 0 7) | - | _ | - | 01 + 2•n | 3 | 5 | | | | |
| Set Bit n | BSET n (n = 0 7) | 10 + 2•n | 2 | 5 | _ | _ | _ | | | | |
| Clear Bit n | BCLR n (n = 0 7) | 11 + 2•n | 2 | 5 | - | _ | - | | | | |

TABLE 8 - CONTROL INSTRUCTIONS

| | | | Inherent | |
|--------------------------|----------|------------|------------|-------------|
| Function | Mnemonic | Op Code | # Bytes | # Cycles |
| Transfer A to X | TAX | 97 | 1 | 2 |
| Transfer X to A | TXA | 9F | 1 | 2 |
| Set Carry Bit | SEC | 99 | 1 | 2 |
| Clear Carry Bit | CLC | 98 | 1 | 2 |
| Set Interrupt Mask Bit | SEI | 9B | 1 | 2 |
| Clear Interrupt Mask Bit | CLI | 9A | 1 | 2 |
| Software Interrupt | SWI | 83 | 1 | 10 |
| Return from Subroutine | RTS | 81 | 1 | 6 |
| Return from Interrupt | RTI | 80 | 1 | 9 |
| Reset Stack Pointer | RSP | 9C | 1 | 2 |
| No-Operation | NOP | 9D | 1 | 2 |
| Stop | STOP | 8E | 1 | 2 |
| Wait | WAIT | 8F | 1 | 2 |

TABLE 9- INSTRUCTION SET OPCODE MAP

| | Bit Ma | nipulation | Branch | T | Re | ad/Modify/ | Write | | Cor | ntrol | | | Regist | er/Memory | | | |
|-----------|-----------------|------------------|--------------|--------------|---------------|-----------------|-----------|-----------|--------------|--------------|----------------|----------------|--------------|--------------|-----------|--------|-----------|
| | BTB | BSC | REL 2 | DIR | INH(A) | INH(X) | IX1 | IX | INH | INH | IMM | DIR | EXT | IX2 | IX1 | IX | |
| Low | 0000 | 0001 | 0010 | 3 0011 | 4 0100 | 5 0101 | 6 0110 | 7 0111 | 1000 | 9 1001 | 1010 | B 1011 | C 1100 | D 1101 | E 1110 | 1111 | Hi |
| 0000 | BRSETO 3 BTB | BSET0 2 BSC | BRA 2 REL | NEG DIR | NEGA 1 INH | NEGX 1 INH | NEG EXT | NEG 1 | RTI 1 INH | | SUB 2 2 IMM | SUB 2 DIR | SUB 3 EXT | SUB 3 IX2 | SUB 1X1 | SUB 3 | 0 |
| 1 0001 | BRCLRO 3 BTB | BCLR0 2 BSC | BRN 2 REL | | | | | | RTS 1 INH | | CMP 2 | CMP 2 DIR | CMP 3 EXT | | CMP 2 X1 | CMP IX | 1 0001 |
| 2 0010 | BRSET1 3 BTB | BSET1 2 BSC | BHI 2 REL | | | | | | | | SBC 2 IMM | SBC 3 2 DIR | | SBC 5 | SBC 4 | SBC 3 | 2 0010 |
| 3 0011 | BRCLR1 3 BTB | BCLR1 2 BSC | BLS REL | СОМ | COMA 1 INH | COMX 1 INH | COM 2 IX1 | COM 1X | SWI 1 INH | | CPX 2 IMM | CPX DIR | CPX 3 EXT | | CPX 4 | CPX 1 | 3 0011 |
| 4 0100 | BRSET2 3 BTB | BSET2 5 2 BSC | BCC BEL | LSR DIR | LSRA 1 INH | LSRX 1 / INH | LSR 2 IX1 | LSR 1 IX | | | AND 2 | AND 2 DIR | | | AND 2 IX1 | AND 3 | 4 0100 |
| 5 0101 | BRCLR2 3 BTB | BCLR2 5 2 BSC | BCS REL | | | | | | | | BIT 2 | BIT DIR | BIT 3 EXT | | BIT 4 | BIT IX | 5 0101 |
| 6 0110 | BRSET3 3 BTB | BSET3 5 2 BSC | | ROR 2 DIR | RORA 3 | RORX 3 | ROR 2 IX1 | ROR 5 | | | LDA 2 2 IMM | LDA 2 DIR | LDA 3 EXT | | LDA 1X1 | LDA 3 | 6 0110 |
| 7 0111 | BRCLR3 3 BTB | | BEQ 3 | ASR 2 DIR | ASRA 3 | ASRX 3 | ASR 2 IX1 | ASR 1X | | TAX 1 INH | | STA 2 DIR | | STA 1X2 | STA 5 | STA 1X | 7 0111 |
| 8 1000 | BRSET4 3 BTB | BSET4 2 BSC | BHCC 3 | LSL 2 DIR | LSLA 1 INH | LSLX 3 | LSL 6 | LSL 1 | | CLC 1 INH | EOR 2 | EOR 2 DIR | EOR SEXT | EOR 3 IX2 | EOR IX1 | EOR 3 | 8 1000 |
| 9 | BRCLR4 3 BTB | BCLR4 2 BSC | BHCS 3 | ROL | ROLA 1 INH | ROLX 1 | ROL 1X1 | ROL 1X | | SEC 1 INH | ADC 2 | ADC 2 DIR | ADC 3 EXT | | ADC 1X1 | ADC 1X | 9 1001 |
| A 1010 | BRSET5 3 BTB | BSET5 5 | BPL | DEC DIR | DECA 1 INH | DECX 1 INH | DEC 1X1 | DEC 1 IX | | CLI 1 INH | ORA 2 | ORA 2 DIR | ORA 3 EXT | ORA 1X2 | ORA X | ORA 1 | A 1010 |
| B 1011 | BRCLR5 3 BTB | BCLR5 2 BSC | BMI 2 REL | | _ | | | | | SEI 1 INH | ADD 2 | ADD 3 | | | ADD 1X1 | ADD IX | B 1011 |
| C 1100 | BRSET6 | BSET6 5 | BMC 3 | INC DIR | INCA 1 INH | INCX 1 INH | INC 6 | INC 1 | | RSP 1 INH | | JMP 2 | JMP 3 EXT | JMP 3 1X2 | JMP 3 | JMP 1X | C 1100 |
| D 1101 | BRCLR6 3 BTB | BCLR6 5 2 BSC | BMS 3 | TST DIR | TSTA 1 INH | TSTX 1 INH | TST 5 | TST IX | | NOP 1 INH | BSR REL | JSR 2 DIR | JSR 3 EXT | JSR 3 IX2 | JSR 2 IX1 | JSR 1 | D 1101 |
| E 1110 | BRSET7 | BSET7 BSC | BIL 2 REL 3 | | | | | | STOP 2 | | LDX 2 | LDX DIR | LDX 3 EXT | | LDX 4 | LDX IX | E 1110 |
| F 1111 | BRCLR7 3 BTB | BCLR7 | l BIH | I CLR | CLRA 1 INH | CLRX 1 INH | CLR 1X1 | CLR IX | WAIT 1 | TXA 2 | | STX DIR | STX 3 EXT | STX | STX 1X1 | STX 1 | F 1111 |

Abbreviations for Address Modes

INH Inherent IMM Immediate DIR Direct **EXT** Extended REL Relative BSC Bit Set/Clear BTB Bit Test and Branch IX Indexed (No Offset) IX1 Indexed, 1 Byte (8-Bit) Offset IX2 Indexed, 2 Byte (16-Bit) Offset

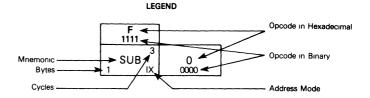


TABLE 10 - INSTRUCTION SET

| | <u> </u> | | | | ddressing | Modes | | | | | Cor | ndit | ion | Co | des |
|------------|--------------|---------------------------------------|--------------|--------------|---------------------------|------------------------|---------------------|---------------------------------------|----------------------|-------------------------|-----|------|-----|----|-----|
| Mnemonic | Inherent | Immediate | Direct | Extended | Relative | Indexed (No Offset) | Indexed (8 Bits) | Indexed (16 Bits) | Bit Set/ Clear | Bit Test & Branch | н | 1 | N | z | С |
| ADC | | X | Х | X | | X | Х | X | | | Λ | • | Λ | Λ | |
| ADD | | X | X | X | | X | X | X | | | Λ | • | | Λ | |
| AND | | X | Х | X | | X | Х | X | | | • | • | Λ | Λ | • |
| ASL | X | | X | | | X | X | | | | • | • | Λ | Λ | Λ |
| ASR | X | | X | | | X | X | | | | • | • | Λ | Λ | 1 |
| BCC | | | | | X | | | | | | • | • | • | • | • |
| BCLR | | | | | | | | | × | | • | • | • | • | • |
| BCS | | | | ļ | X | ļ | | | | | • | • | • | • | • |
| BEQ | | | | | X | | | | | | • | • | • | • | • |
| BHCC | | ļ | | | X | | | | | | • | • | • | • | • |
| BHCS | | | | | X | | | | | | • | • | • | • | • |
| BHI | | | ļ | | X | | | | - | | • | • | • | • | • |
| BHS | | | | | X | | | | | | • | • | • | • | - |
| BIH | | | ļ | ļ | - X | | | | | | • | - | • | • | - |
| | ļ | | | | | | | | | | | • | | | - |
| BIT BLO | | X | X | X | × | X | Х | X | | | • | • | Λ | Λ | - |
| | | | | | X | | | ļ | | | • | • | • | • | • |
| BLS BMC | <u> </u> | | | | X | | | | | | • | • | • | - | - |
| BMI | | | | | x | | | | | | • | • | • | • | - |
| BMS | | | | | - x | | | | | | • | • | • | • | • |
| BNE | | | | | - x | | | | | | • | • | • | • | • |
| BPL | | | | | - x | | | | | | • | • | • | • | • |
| BRA | | | | | × | | | | - | | • | • | • | • | • |
| BRN | | | ļ | | X | | | | - | | • | • | • | • | - |
| BRCLR | | | | | ^ | | | | | × | | • | • | • | A |
| BRSET | | | | | | | | | | x | • | • | • | • | Ä |
| BSET | | | | | | | | | X | | • | • | • | • | · |
| BSR | | | ļ | | X | ļ | | | <u> </u> | | • | • | • | • | 1 |
| CLC | × | | | | | | | | | | • | • | • | • | 10 |
| CLI | x | | | | ļ | | | | | | • | 0 | • | • | • |
| CLR | x | | × | | | × | X | | | | • | • | 0 | 1 | • |
| CMP | | × | X | × | · | × | X | X | | | • | • | Λ | Λ | |
| COM | X | · · · · · · · · · · · · · · · · · · · | X | | | × | X | · · · · · · · · · · · · · · · · · · · | | | • | • | Λ | Λ | 17 |
| CPX | | × | X | × | | X | X | X | | | • | • | Λ | Ā | |
| DEC | X | | X | | | X | X | | | | • | • | Λ | Λ | |
| EOR | | X | X | × | | X | X | X | | | • | • | Λ | | |
| INC | X | | X | | | X | X | | | | • | • | Λ | | • |
| JMP | | | X | X | | X | X | X | | | • | • | • | • | |
| JSR | | | X | X | | X | X | X | | | • | • | • | • | • |
| LDA | | X | × | X | | X | X | X | | | • | • | Λ | Λ | • |
| LDX | | X | X | X | | X | X | X | | | • | • | Λ | Λ | • |
| LSL | Х | | X | | | X | X | | | | • | • | Λ | Λ | Λ |
| LSR | Х | | X | | | X | X | | | | • | • | 0 | Λ | Λ |
| NEG | Х | | X | | | X | X | | | | • | • | Λ | Λ | Λ |
| NOP | Х | | | | | | | | | | • | • | • | • | • |
| ORA | | X | X | X | | X | X | X | | | • | • | Λ | Λ | • |
| ROL | X | | X | | | X | X | | | | • | • | Λ | Λ | Λ |
| ROR | X | | X | | | X | X | | | | • | • | Λ | Λ | |
| RSP | Х | | | | | | | | | | • | • | • | • | • |
| RTI | X | | | | | | | | | | 7 | 7 | 7 | 7 | 7 |
| RTS | X | | | l | | | | | | | • | • | • | • | • |
| SBC | | X | Х | X | | X | X | X | | | • | • | Λ | Λ | Λ |
| SEC | X | | | | | | | | | | • | • | • | • | 1 |
| SEI | X | | | | | | | | | | • | 1 | • | • | • |
| STA | | | Х | X | | X | X | X | | | • | • | Λ | Λ | • |
| STOP | X | | | | | | | | | | • | 0 | • | • | |
| STX | | | Х | X | | Х | X | Х | | | • | • | Λ | Λ | |
| SUB | | X | Х | X | | X | X | X | | | • | • | Λ | Λ | Λ |
| SWI | Х | | | | | | | | | | • | 1 | • | • | • |
| TAX | X | | | | | | | | | | • | • | • | | • |
| TST | X | | X | | | X | X | | | | • | • | Λ | Λ | |
| TXA | X | | | | | | | | | | • | • | • | • | |
| WAIT | X | | | 1 | | 1 | | | | | • | 0 | • | • | • |

Condition Code Symbols

- H Half Carry (From Bit 3)
 I Interrupt Mask
 N Negative (Sign Bit)
 Z Zero
 C Carry/Borrow

- Test and Set if True Cleared Otherwise
 Not Affected
 Load CC Register From Stack
- 0 Cleared 1 Set

ORDERING INFORMATION

The following information is required when ordering a custom MCU. This information may be transmitted to Motorola in the following media.

EPROM(s) MCM2716s or MCM2708s

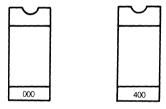
MDOS disk file

To initiate a ROM pattern for the MCU it is necessary to first contact your local field service office, local sales person, or your local Motorola representative

EPROMs — The MCM2708 or MCM2716 type EPROMs, programmed with the customer program (positive logic sense for address and data), may be submitted for pattern generation. The EPROMs must be clearly marked to indicate which EPROM corresponds to which address space. See Figure A-1 for recommended marking procedure.

After the EPROM(s) are marked they should be placed in conductive IC carriers and securely packed. Do not use styrofoam.

FIGURE A-1 - EPROM MARKING



xxx = Customer ID

VERIFICATION MEDIA

All original pattern media (EPROMs or Floppy Disk) are filed for contractual purposes and are not returned. A computer listing of the ROM code will be generated and returned

along with a listing verification form. The listing should be thoroughly checked and the verification form completed, signed, and returned to Motorola. The signed verification form constitutes the contractual agreement for creation of the customer mask. If desired, Motorola will program a blank 2716 EPROM (supplied by the customer) from the data file used to create the custom mask to aid in the verification process.

ROM VERIFICATION UNITS

Ten MC146805G2s containing the customer's ROM pattern will be sent for program verification. These units will have been made using the custom mask but are for the purpose of ROM verification only. For expediency they are usually unmarked, packaged in ceramic, and tested only at room temperature and 5 volts. These RVUs are included in the mask charge and are not production parts. These RVUs are not backed nor guaranteed by Motorola Quality.

FLEXIBLE DISKS

The disk media submitted must be single-sided, singledensity, 8-inch, MDOS compatible floppies. The customer must write the binary file name and company name on the disk with a felt-tip pen. The floppies are not to be returned by Motorola as they are used for archival storage. The minimum MDOS system files as well as the absolute binary object file (file name LO type of file) from the M6805 cross assembler must be on the disk. An object file made from a memory dump using the ROLLOUT command is also admissable Consider submitting a source listing as well as the following files: filename.LX (EXORciser© loadable format) and filename SA (ASCII Source Code) These files will of course be kept confidential and are used 1) to speed up the process in house if any problems arise, and 2) to speed up our customer to factory interface if a user finds any software errors and needs assistance quickly from the factory representatives

MDOS is Motorola's Disk Operating System available on development systems such as EXORcisers, or EXORsets, etc

Option List

| Select the options for your MCU from the following list. A manufacturing mask will be generated from this information. Selection. In each section. | :t |
|---|----|
| sternal Oscillator Input Crystal Resistor | |
| nternal Divide | |
| aterrupt □ Edge-Sensitive □ Level- and Edge-Sensitive | |
| Customer Name | |
| Address | |
| City State Zip | |
| Phone () Extension | |
| Contact Ms/Mr | |
| Customer Part Number | |
| | |
| Pattern Media | |
| 2708 EPROM | |
| 2716 EPROM | |
| MDOS Disk File | |
| Silent 700 Cassette | |
| Card Deck | |
| Tape of Card Deck | |
| (Note 2) | |
| | |
| Notes. (2) Other media require prior factory approval | |
| Signature | |
| Title | |



MC146818

Advance Information

REAL-TIME CLOCK PLUS RAM (RTC)

The MC146818 Real-Time Clock plus RAM is a peripheral device which includes the unique MOTEL concept for use with various microprocessors, microcomputers, and larger computers. This part combines three unique features: a complete time-of-day clock with alarm and one hundred year calendar, a programmable periodic interrupt and square-wave generator, and 50 bytes of low-power static RAM. The MC146818 uses high-speed CMOS technology to interface with 1 MHz processor buses, while consuming very little power.

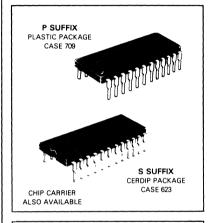
The Real-Time Clock plus RAM has two distinct uses First, it is designed as a battery powered CMOS part (in an otherwise NMOS/TTL system) including all the common battery backed-up functions such as RAM, time, and calendar Secondly, the MC146818 may be used with a CMOS microprocessor to relieve the software of the timekeeping workload and to extend the available RAM of an MPU such as the MC146805E2

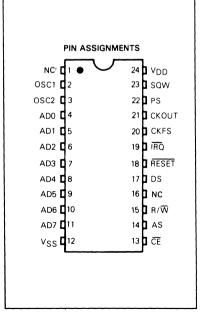
- Low-Power, High-Speed, High-Density CMOS
- Internal Time Base and Oscillator
- · Counts Seconds, Minutes, and Hours of the Day
- · Counts Days of the Week, Date, Month, and Year
- 24-Pin Dual-In-Line Package
- 3 and 5 V Operation
- Time Base Input Options 4 194304 MHz, 1 048576 MHz, or 32 768 kHz
- Time Base Oscillator for Parallel Resonant Crystals
- 40 to 200 μW Typical Operating Power at Low Frequency Time Base
- 4.0 to 20 mW Typical Operating Power at High Frequency Time Base
- Binary or BCD Representation of Time, Calendar, and Alarm
- 12- or 24-Hour Clock with AM and PM in 12-Hour Mode
- Daylight Savings Time Option
- Automatic End of Month Recognition
- Automatic Leap Year Compensation
- Microprocessor Bus Compatible
- MOTEL Circuit for Bus Universality
- Multiplexed Bus for Pin Efficiency
- Interfaced with Software as 64 RAM Locations
- 14 Bytes of Clock and Control Registers
- 50 Bytes of General Purpose RAM
- Status Bit Indicates Data Integrity
- Bus Compatible Interrupt Signals (IRQ)
- Three Interrupts are Separately Software Maskable and Testable
 - Time-of-Day Alarm, Once-per-Second to Once-per-Day
 - Periodic Rates from 30 5 μs to 500 ms
 - End-of-Clock Update Cycle
- Programmable Square-Wave Output Signal
- Clock Output May Be Used as Microprocessor Clock Input
 - At Time Base Frequency +1 or +4
- 24-Pin Dual-In-Line Package
- Chip Carrier Also Available

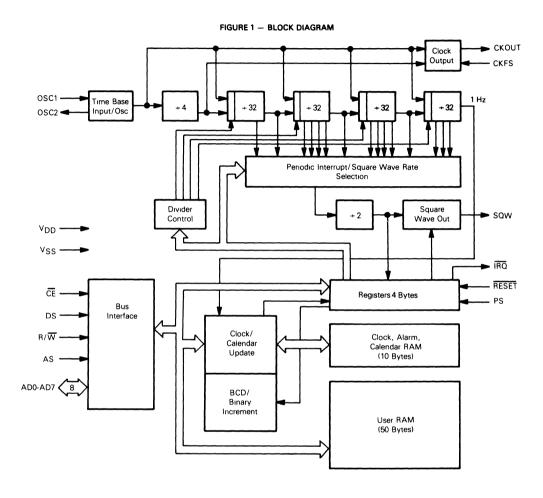
CMOS

(HIGH-PERFORMANCE SILICON-GATE COMPLEMENTARY MOS)

REAL-TIME CLOCK
PLUS RAM







MAXIMUM RATINGS (Voltages referenced to VSS)

| Ratings | Symbol | Value | Unit |
|---|------------------|-------------------|------|
| Supply Voltage | VDD | -0.3 to +8.0 | ٧ |
| All Input Voltages Except OSC1 | V _{in} | VSS-0.5 to VDD+05 | ٧ |
| Current Drain per Pin Excluding VDD and VSS | i | 10 | mA |
| Operating Temperature Range | TA | 0 to +70 | °C |
| Storage Temperature Range | T _{stg} | -55 to +150 | °C |

THERMAL CHARACTERISTICS

| Characteristic | Symbol | Value | Unit |
|-----------------------------------|--------|-----------|------|
| Thermal Resistance Plastic Cerdip | ۵μ | 120 65 | °C/W |

This device contains circuitry to protect the inputs against damage due to high static voltages or electric fields, however, it is advised that normal precautions be taken to avoid application of any voltage higher than maximum rated voltages to this high-impedance circuit. For proper operation it is recommended that V_{in} and V_{out} be constrained to the range V_{SS}≤(V_{in} or V_{out}) ≤V_{CC}. Leakage currents are reduced and reliability of operation is enhanced if unused inputs are tied to an appropriate logic voltage level (e.g., either V_{SS} or V_{CC}).

DC ELECTRICAL CHARACTERISTICS ($V_{DD}=5 \text{ Vdc} \pm \text{TBD}\%$, $V_{SS}=0 \text{ Vdc}$, $T_{A}=0^{\circ}$ to 70°C unless otherwise noted)

| Characteristics | Symbol | Min | Max | Unit |
|--|--------|-----------------------|--------|------------------|
| Frequency of Operation | fosc | 32 768 | 4194 3 | kHz |
| Output Voltage | VOL | _ | 0 1 | ., |
| I _{Load} < 10 μA | Voн | V _{DD} - 0 1 | - | V |
| IDD — Operating f _{OSC} = 4 194304 MHz, | IDD1 | _ | 10 | mA |
| $CKOUT = f_{OSC}$, $C_1 = 130 \text{ pF}$, $C_1 (OSC2) = 10 \text{ pF}$, | | | | 1 |
| SQW Enabled, $C_1 = 50 \text{ pF}$, | | | | l |
| $t_{CVC} = 1 \mu s$, $\overline{CE} = V_{SS} + 0.2 V$, | | | | |
| C _L (Bus) = 130 pF | | | 1 | |
| IDD - Bus Idle | | | | |
| $CKOUT = f_{OSC}, C_{\underline{L}} = 15 pF,$ | | | 1 | |
| SQW Disabled, $\overline{CE} = V_{DD} - 0.2$, | | | | |
| $C_L(OSC2) = 10 \text{ pF}$ | | | _ | |
| f _{osc} = 4 194304 MHz | DD2 | - | 5 2 | mA |
| f _{OSC} = 1 048516 MHz | DD3 | _ | 200 | mA |
| f _{osc} = 32 768 kHz | DD4 | _ | | μΑ |
| IDD - Quiescent | DD5 | - | 100 | μΑ |
| $f_{OSC} = DC$, OSC1 = DC, | | | | |
| All Other Inputs = V _{DD} - 0 2 V, No Clock | | | | |
| Output High Voltage (I _{Load} = -1 6 mA, All Outputs Except TRQ and OSC2) | Voн | 4 1 | | V |
| Output Low Voltage (I _{L Oad} = 1.6 mA, All Outputs Except OSC2) | | | 0.4 | $\frac{1}{V}$ |
| | VOL | | | <u> </u> |
| | ., | V _{DD} - 20 | VDD | ., |
| RESET | VIH | VDD-08 | VDD | ٧ |
| OSC1 | | V _{DD} -10 | VDD | |
| Input Low Voltage AD0-AD7, AS, R/W, CE | | VSS | 0.8 | 1 1 |
| PS, RESET | VIL | VSS | 08 | l _v l |
| OSC1 | ۷IL | VSS | 08 | |
| DS | | V _{SS} | TBD | |

BUS TIMING ($V_{DD} = 5 \text{ Vdc } \pm \text{TBD}\%$, $V_{SS} = 0 \text{ Vdc}$, $T_A = 0^{\circ}$ to 70°C unless otherwise noted)

| ldent. Number | Characteristics | Symbol | Min | Max | Unit |
|------------------|---|---------------------------------|-----|-----|------|
| 1 | Cycle Time | t _{cyc} | 953 | DC | ns |
| 2 | Pulse Width, DS/E Low or RD/WR High | PWEL | 300 | _ | ns |
| 3 | Pulse Width, DS/E High or RD/WR Low | PWEH | 325 | _ | ns |
| 4 | Clock Rise and Fall Time | t _r , t _f | _ | 30 | ns |
| 8 | R/W Hold Time | tRWH | 10 | _ | ns |
| 13 | R/W Setup Time Before DS/E | tRWS | 15 | - | ns |
| 14 | Chip Enable Setup Time Before AS/ALE Fall | tcs | 55 | - | ns |
| 15 | Chip Enable Hold Time | tCH | 0 | _ | ns |
| 18 | Read Data Hold Time | tDHR | 10 | 100 | ns |
| 21 | Write Data Hold Time | tDHW | 0 | - | ns |
| 24 | Muxed Address Valid Time to AS/ALE Fall | tASL | 50 | - | ns |
| 25 | Muxed Address Hold Time | tAHL | 50 | - | ns |
| 26 | Delay Time DS/E to AS/ALE Rise | tASD | 50 | - | ns |
| 27 | Pulse Width, AS/ALE High | PWASH | 100 | - | ns |
| 28 | Delay Time, AS/ALE to DS/E Rise | tASED | 90 | _ | ns |
| 30 | Peripheral Output Data Delay Time From DS/E or RD | tDDR | 20 | 240 | ns |
| 31 | Peripheral Data Setup Time | tDSW | 220 | | ns |

Note Designations E, ALE, $\overline{\text{RD}}$, and $\overline{\text{WR}}$ refer to signals from alternative microprocessor signals

FIGURE 3 — BUS READ TIMING COMPETITOR MULTIPLEXED BUS

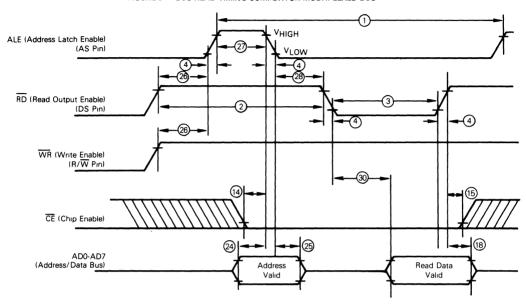
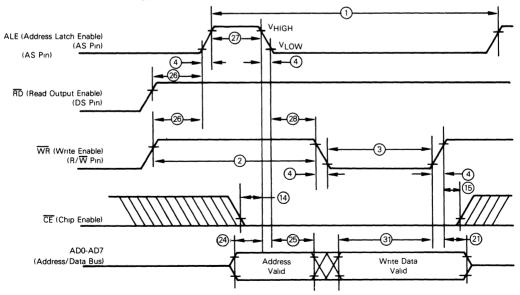


FIGURE 4 - BUS WRITE TIMING COMPETITOR MULTIPLEXED BUS

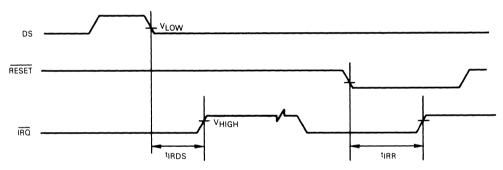


NOTE $V_{HIGH} = V_{DD} - 2.0 \text{ V}$, $V_{LOW} = 0.8 \text{ V}$, for $V_{DD} = 5.0 \text{ V} \pm \text{TBD}\%$

TABLE 1 — SWITCHING CHARACTERISTICS (V_{DD} =5 0 Vdc \pm TBD%, V_{SS} =0 Vdc, T_{A} =0° to 70°C)

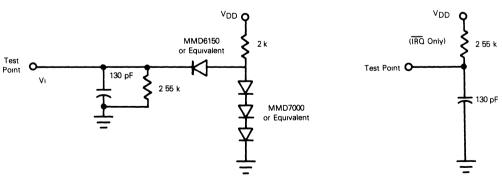
| Description | Symbol | Min | Max | Unit |
|-------------------------|------------------|-----|-----|------|
| Oscillator Startup | t _{RC} | _ | 100 | ms |
| Reset Pulse Width | ^t RWL | 5 | | μS |
| Reset Delay Time | trlh | 5 | _ | μS |
| Power Sense Pulse Width | tPWL | 5 | _ | μS |
| Power Sense Delay Time | ^t PLH | 5 | _ | μS |
| IRQ Release from DS | tirds | 2 | _ | μS |
| IRQ Release from RESET | tirr | 2 | _ | μS |
| VRT Bit Delay | tVRTD | 2 | _ | μS |

FIGURE 5 - IRQ RELEASE DELAY

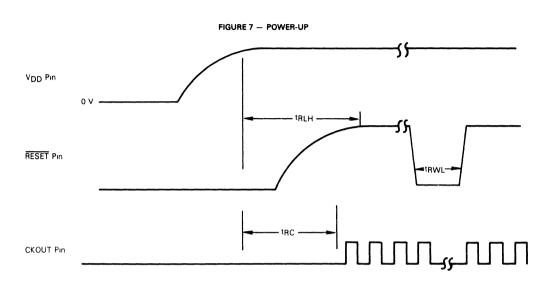


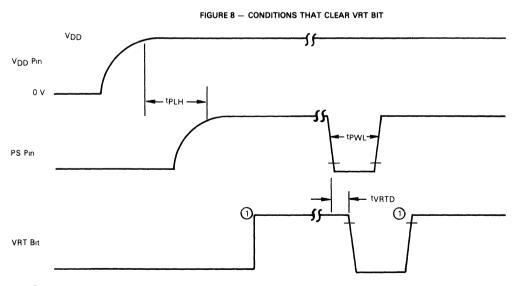
NOTE $V_{HIGH} = V_{DD} - 20 \text{ V}$, $V_{LOW} = 0.8 \text{ V}$, for $V_{DD} = 5.0 \text{ V} \pm \text{TBD}\%$

FIGURE 6 - TTL EQUIVALENT TEST LOAD



All Outputs Except OSC2 (See Figure 10)





1 The VRT bit is set to a "1" by reading Control Register #D There is no additional way to clear the VRT Bit (see section on VRT)

MOTEL

The MOTEL circuit is a new concept that permits the MC146818 to be directly interfaced with many types of microprocessors. No external logic is needed to adapt to the differences in bus control signals from common multiplexed bus microprocessors.

Practically all microprocessors interface with one of two synchronous bus structures. One bus was originated by the Motorola MC6800 and the other by the Intel 8080 and its companion part, the 8228

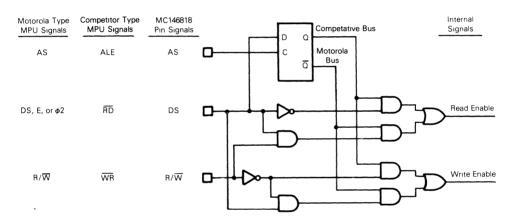
The MOTEL circuit (for <u>MOT</u>orola and Int<u>EL</u> bus compatibility) is built into peripheral and memory ICs to permit direct connection to either type of bus. An industry standard

bus structure is now available. The MOTEL concept is shown logically in Figure 9.

MOTEL selects one of two interpretations of two pins. In the Motorola case, DS and R/\overline{W} are gated together to produce the internal read enable. The internal write enable is a similar gating of the inverse of R/\overline{W} . With competitor buses, the inversion of \overline{RD} and \overline{WR} create functionally identical internal read and write enable signals.

The MC146818 automatically selects the processor type by using AS/ALE to latch the state of the DS/ \overline{RD} pin Since DS is always low and \overline{RD} is always high during AS and ALE, the latch automatically indicates which processor type is connected

FIGURE 9 - FUNCTIONAL DIAGRAM OF MOTEL CIRCUIT



SIGNAL DESCRIPTIONS

The block diagram in Figure 1, shows the pin connection with the major internal functions of the MC146818 Real-Time Clock plus RAM. The following paragraphs describe the function of each pin

V_{DD}, V_{SS}

DC power is provided to the part on these two pins, V_{DD} being the most positive voltage. The minimum and maximum voltages are listed in the Electrical Characteristics tables.

OSC1, OSC2 - TIME BASE, INPUTS

The time base for the time functions may be an external signal or the crystal oscillator. External square waves at 4.194304 MHz, 1.048576 MHz, or 32.768 kHz may be connected to OSC1 as shown in Figure 10. The time-base frequency to be used is chosen in Register A.

The on-chip oscillator is designed for a parallel resonant

AT cut fundamental crystal at 4 194304 MHz or 1 048576 MHz The crystal connections are shown in Figure 11 and the crystal characteristics in Figure 12.

CKOUT - CLOCK OUT, OUTPUT

The CKOUT pin is an output at the time-base frequency divided by 1 or 4. A major use for CKOUT is as the input clock to the microprocessor, thereby saving the cost of a second crystal. The frequency of CKOUT depends upon the time-base frequency and the state of the CKFS pin as shown in Table 2.

CKFS - CLOCK OUT FREQUENCY SELECT, INPUT

The CKOUT pin is an output at the time-base frequency divided by 1 or 4. CKFS tied to V_{DD} causes CKOUT to be the same frequency as the time base at the OSC1 pin. When CKFS is at V_{SS} , CKOUT is the OSC1 time-base frequency divided by four. Table 2 summarizes the effect of CKFS

FIGURE 10 - EXTERNAL TIME-BASE CONNECTION

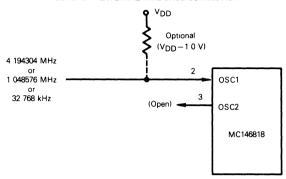


FIGURE 11 - CRYSTAL OSCILLATOR CONNECTION

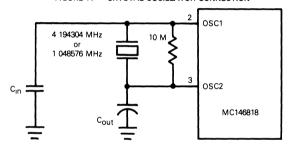
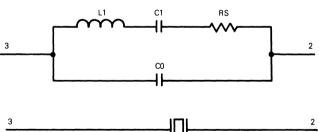


FIGURE 12 - CRYSTAL PARAMETERS

Crystal Equivalent Circuit



| fosc | 4.194304 MHz | 1.048576 MHz |
|-----------------------------------|--------------|--------------|
| Rs max | 75 Ω | 400 Ω |
| C0 max 1 | 7 pF | 5 pF |
| C1 | 0.012 pF | 0.008 pF |
| C _{in} /C _{out} | 15-30 pF | 15-40 pF |
| Q | 50 k | 35 k |

TABLE 2 - CLOCK OUTPUT FREQUENCIES

| Time Base (OSC1) Frequency | Clock Frequency Select Pin (CKFS) | Clock Frequency Output Pin (CKOUT) |
|----------------------------------|---|------------------------------------|
| 4 194304 MHz | Hıgh | 4.194304 MHz |
| 4.194304 MHz | Low | 1 048576 MHz |
| 1 048576 MHz | High | 1.048576 MHz |
| 1 048576 MHz | Low | 262.144 kHz |
| 32 768 kHz | High | 32 768 kHz |
| 32 768 kHz | Low | 8.192 kHz |

SQW - SQUARE WAVE, OUTPUT

The SQW pin can output a signal one of 15 of the 22 internal-divider stages. The frequency and output enable of the SQW may be altered by programming Register A, as shown in Table 5. The SQW signal may be turned on and off using a bit in Register B.

AD0-AD7 — MULTIPLEXED BIDIRECTIONAL ADDRESS/DATA BUS

Multiplexed bus processors save pins by presenting the address during the first portion of the bus cycle and using the same pins during the second portion for data. Address-then-data multiplexing does not slow the access time of the MC146818 since the bus reversal from address to data is occurring during the internal RAM access time

The address must be valid just prior to the fall of AS/ALE at which time the MC146818 latches the address from AD0 valid write data must be presented and held stable during the latter portion of the DS or WR pulses. In a read cycle, the MC146818 outputs 8 bits of data during the latter portion of the DS or RD pulses, then ceases driving the bus returns the output drivers to three-state) when DS falls in the Motorola case of MOTEL or RD rises in the other case.

AS - MULTIPLEXED ADDRESS STROBE, INPUT

A positive going multiplexed address strobe pulse serves to demultiplex the bus. The falling edge of AS or ALE causes the address to be latched within the MC146818. The automatic MOTEL in the MC146818 also latches the state of the DS pin with the falling edge of AS or ALE

DS - DATA STROBE OR READ, INPUT

The DS pin has two interpretations via the MOTEL circuit. When emanating from a Motorola type processor, DS is positive pulse during the latter portion of the bus cycle, and is vanously called DS (data strobe), E (enable), and ϕ 2 (ϕ 2 clock). During read cycles, DS signifies the time that the RTC is to drive the bidirectional bus. In write cycles, the trailing edge of DS causes the Real-Time Clock plus RAM to latch the written data.

The second MOTEL interpretation of DS is that of RD, MEMR, or I/OR emanating from the competitor type processor. In this case, DS identifies the time period when the real-time clock plus RAM drives the bus with read data. This interpretation of DS is also the same as an output-enable signal on a typical memory.

The MOTEL circuit, within the MC146818, latches the state of the DS pin on the falling edge of AS/ALE. When the Motorola mode of MOTEL is desired DS must be low during AS/ALE, which is the case with the Motorola multiplexed

bus processors. To insure the competitor mode of MOTEL, the DS pin must remain high during the time AS/ALE is high.

R/W - READ/WRITE, INPUT

The MOTEL circuit treats the R/\overline{W} pin in one of two ways. When a Motorola type processor is connected, R/\overline{W} is a level which indicates whether the current cycle is a read or write. A read cycle is indicated with a high level on R/\overline{W} while DS is high, whereas a write cycle is a low on R/\overline{W} during DS.

The second interpretation of R/\overline{W} is as a negative write pulse, \overline{WR} , \overline{MEMW} , and $\overline{I/OW}$ from competitor type processors. The MOTEL circuit in this mode gives R/\overline{W} pin the same meaning as the write (W) pulse on many generic RAMs

CE - CHIP ENABLE, INPUT

The chip-enable ($\overline{\text{CE}}$) signal must be asserted (low) for a bus cycle in which the MC146818 is to be accessed $\overline{\text{CE}}$ is not latched and must be stable during DS and AS (in the other Motorola case of MOTEL) and during $\overline{\text{RD}}$ and $\overline{\text{WR}}$ (in the MOTEL case) Bus cycles which take place without asserting $\overline{\text{CE}}$ cause no actions to take place within the MC146818 When $\overline{\text{CE}}$ is high, the multiplexed bus output is in a high-impedance state

When \overline{CE} is high, all address, data, DS, and R/ \overline{W} inputs from the processor are disconnected within the MC146818. This permits the MC146818 to be isolated from a powered-down processor. When \overline{CE} is held high, an unpowered device cannot receive power through the input pins from the real-time clock power source. Battery power consumption can thus be reduced by using a pullup resistor or active clamp on \overline{CE} when the main power is off

IRQ - INTERRUPT REQUEST, OUTPUT

The \overline{IRQ} pin is an active low output of the MC146818 that may be used as an interrupt input to a processor. The \overline{IRQ} output remains low as long as the status bit causing the interrupt is present and the corresponding interrupt-enable bit is set. To clear the \overline{IRQ} pin, the processor program normally reads Register C. The \overline{RESET} pin also clears pending interrupts.

When no interrupt conditions are present, the \overline{IRQ} level is in the high-impedance state Multiple interrupting devices may thus be connected to an \overline{IRQ} bus with one pullup at the processor.

RESET - RESET, INPUT

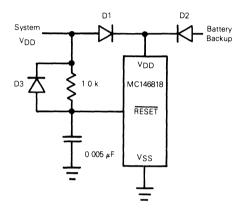
The $\overline{\text{RESET}}$ pin does not affect the clock, calendar, or RAM functions. On powerup, the $\overline{\text{RESET}}$ pin must be held low for the specified time, tRLH, in order to allow the power supply to stabilize. Figure 13 shows a typical representation of the $\overline{\text{RESET}}$ pin circuit

When RESET is low the following occurs:

- a) Periodic Interrupt Enable (PIE) bit is cleared to zero,
- b) Alarm Interrupt Enable (AIE) bit is cleared to zero,
- Update ended Interrupt Enable (UIE) bit is cleared to zero,
- d) Update ended Interrupt Flag (UF) bit is cleared to zero,
- e) Interrupt Request status Flag (IRQF) bit is cleared to
- f) Periodic Interrupt Flag (PF) bit is cleared to zero,

- g) Alarm Interrupt Flag (AF) bit is cleared to zero,
- h) IRQ pin is in high-impedance state, and
- Square Wave output Enable (SQWE) bit is cleared to zero

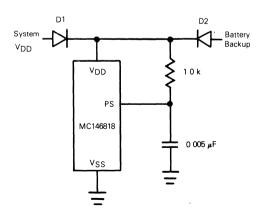
FIGURE 13 — TYPICAL POWERUP DELAY CIRCUIT FOR RESET



D1 = D2 = D3 = 1N4148 or Equivalent

Note If the RTC is isolated from the MPU or MCU power by a diode drop, care must be taken to meet $V_{\rm IR}$ requirements

FIGURE 14 — TYPICAL POWERUP DELAY CIRCUIT FOR POWER SENSE



D1 = D2 = 1N4148 or Equivalent

PS - POWER SENSE, INPUT

The power-sense pin is used in the control of the valid RAM and time (VRT) bit in Status Register 1. When the PS pin is low the VRT bit is cleared to zero

During powerup, the PS pin must be externally held low for the specified time, tpl. As power is applied the VTR bit remains low indicating that the contents of the RAM, time registers, and calendar are not guaranteed. When normal operation commences PS should be permitted to go high. Figure 14 shows a typical circuit connection for the power-sense pin

POWER-DOWN CONSIDERATIONS

In most systems, the MC146818 must continue to keep time when system power is removed. In such systems, a conversion from system power to an alternate power supply, usually a battery, must be made. During the transition from system to battery power, the designer of a battery backed-up RTC system must protect data integrity, minimize power consumption, and ensure hardware reliability.

The chip enable (\overline{CE}) pin controls all bus inputs $(R/\overline{W}, DS, AS, AD0-AD7)$ \overline{CE} , when negated, disallows any unintended modification of the RTC data by the bus \overline{CE} also reduces power consumption by reducing the number of transitions seen internally

Power consumption may be further reduced by removing resistive and capacitive loads from the clock out (CKOUT) pin and the squarewave (SQW) pin

During and after the power source conversion, the V_{IN} maximum specification must never be exceeded Failure to meet the V_{IN} maximum specification can cause a virtual SCR to appear which may result in excessive current drain and destruction of the part

ADDRESS MAP

Figure 15 shows the address map of the MC146818 The memory consists of 50 general purpose RAM bytes, 10 RAM bytes which normally contain the time, calendar, and alarm data, and four control and status bytes. All 64 bytes are directly readable and writable by the processor program except Registers C and D which are read only Bit 7 of Register A and the seconds byte are also read only Bit 7, of the second byte, always reads "0". The contents of the four control and status registers are described in the Register section

TIME, CALENDAR, AND ALARM LOCATIONS

The processor program obtains time and calendar information by reading the appropriate locations. The program may initialize the time, calendar, and alarm by writing to these RAM locations. The contents of the 10 time, calendar, and alarm byte may be either binary or binary-coded decimal (BCD).

Before initializing the internal registers, the SET bit in Register B should be set to a "1" to prevent time/calendar updates from occurring. The program initializes the 10 locations in the selected format (binary or BCD), then indicates the format in the data mode (DM) bit of Register B All 10 time, calendar, and alarm bytes must use the same data mode, either binary or BCD. The SET bit may now be cleared to allow updates. Once initialized the real-time clock makes all updates in the selected data mode. The data mode cannot be changed without reinitializing the 10 data bytes.

Table 3 shows the binary and BCD formats of the 10 time, calendar, and alarm locations. The 24/12 bit in Register B establishes whether the hour locations represent 1-to-12 or

0-to-23 The 24/12 bit cannot be changed without reinitializing the hour locations. When the 12-hour format is selected the high-order bit of the hours byte represents PM when it is a "1".

The time, calendar, and alarm bytes are not always accessable by the processor program. Once-per-second the 10 bytes are switched to the update logic to be advanced by one second and to check for an alarm condition. If any of the 10 bytes are read at this time, the data outputs are undefined. The update lockout time is 248 μs at the 4 194304 MHz and 1 048567 MHz time bases and 1948 μs for the 32 768 kHz time base. The Update Cycle section shows how to accommodate the update cycle in the processor program

FIGURE 15 - ADDRESS MAP

| 0 13 14 | 14 Bytes 50 Bytes User RAM | OD OE | | 1 | Seconds Sec Alarm Minutes Min Alarm Hours Hr Alarm Day of Wk Date of Mo Month Year Register A Register B | 00 01 02 03 04 05 06 07 08 09 0A | Binary or BCD Contents |
|---------------|---|-------|---|---|--|--|------------------------------|
| | | | 1 | 2 | Register C | 0C | |
| 63 | | 3F | 1 | 3 | Register D | 0D | |

TABLE 3 - TIME, CALENDAR, AND ALARM DATA MODES

| Address | | Decimal | Pango of PAM | in Havadasimal | Example | in Hex |
|----------|-------------------------------|---------|--------------------------------------|--------------------------------------|---------------------|------------------|
| Location | Function | Range | | | Binary Data Mode | BCD Data Mode |
| 0 | Seconds | 0-59 | \$00-\$3B | \$00-\$59 | 15 | 21 |
| 1 | Seconds Alarm | 0-59 | \$00-\$3B | \$00-\$59 | 15 | 21 |
| 2 | Minutes | 0-59 | \$00-\$3B | \$00-\$59 | 3A | 58 |
| 3 | Minutes Alarm | 0-59 | \$00-\$3B | \$00-\$59 | 3A | 58 |
| | Hours (12 Hour Mode) | 1-12 | \$01-10C (AM) and \$81-\$8C (PM) | \$01-\$12 (AM) and \$81-\$92 (PM) | 05 | 05 |
| 4 | Hours (24 Hour Mode) | 0-23 | \$00-\$17 | \$00-\$23 | 05 | 05 |
| 5 | Hours Alarm (12 Hour Mode) | 1-12 | \$01-\$0C (AM) and \$81-\$8C (PM) | \$01-\$12 (AM) and \$81-\$92 (PM) | 05 | 05 |
| | Hours Alarm (24 Hour Mode) | 0-23 | \$00-\$17 | \$00-23 | 05 | 05 |
| 6 | Day of the Week Sunday = 1 | 1-7 | \$01-\$07 | \$01-\$07 | 05 | 05 |
| 7 | Day of the Month | 1-31 | \$01-\$1F | \$01-\$31 | 0F | 15 |
| 8 | Month | 1-12 | \$01-\$0C | \$01-\$12 | 02 | 02 |
| 9 | Year | 0-99 | \$00-\$63 | \$00-\$99 | 4F | 79 |

^{*}Example: 5:58:21 Thursday February 1979

The three alarm bytes may be used in two ways. When the program inserts an alarm time in the appropriate hours, minutes, and seconds alarm locations, the alarm interrupt is initiated at the specified time each day if the alarm enable bit is high. The alternate usage is to insert a "don't care" state in one or more of three alarm bytes. The "don't care" code is any hexadecimal byte from C0 to FF. That is, the two most-significant bits of each byte, when set to "1", create a "don't care" situation. An alarm interrupt each hour is created with a "don't care" code in the hours alarm location. Similarly, an alarm is generated every minute with "don't care" codes in the hours and minutes alarm bytes. The "don't care" codes in all three alarm bytes create an interrupt every second.

STATIC CMOS RAM

The 50 general purpose RAM bytes are not dedicated within the MC146818. They can be used by the processor program, and are fully available during the update cycle.

When time and calendar information must use battery back-up, very frequently there is other non-volatile data that must be retained when main power is removed. The 50 user RAM bytes serve the need for low-power CMOS battery-backed storage, and extend the RAM available to the program.

When further CMOS RAM is needed, additional MC146818s may be included in the system. The time/calendar functions may be disabled by holding the dividers, in Register A, in the reset state by setting the SET bit in CR2 or by removing the oscillator. Holding the dividers in reset prevents interrupts or SQW output from operating while setting the SET bit allows these functions to occur. With the dividers clear, the available user RAM is extended to 59 bytes. Bit 7 of Register A, Status Registers A and B, and the high-order Bit of the seconds byte cannot effectively be used as general purpose RAM.

INTERRUPTS

The RTC plus RAM includes three separate fully automatic sources of interrupts to the processor. The alarm interrupt may be programmed to occur at rates from once-per-second to one-a-day. The periodic interrupt may be selected for rates from half-a-second to 30 517 μs . The update-ended interrupt may be used to indicate to the program that an update cycle is completed. Each of these independent interrupt conditions are described in greater detail in other sections.

The processor program selects which interrupts, if any, it wishes to receive Three bits in Register B enable the three interrupts. Writing a "1" to a interrupt-enable bit permits that interrupt to be initiated when the event occurs. A "0" in the interrupt-enable bit prohibits the IRQ pin from being asserted due to the interrupt cause.

If an interrupt flag is already set when the interrupt becomes enabled, the $\overline{\text{IRQ}}$ pin is immediately activated, though the interrupt initiating the event may have occurred much earlier Thus, there are cases where the program should clear such earlier initiated interrupts before first enabling new interrupts

When an interrupt event occurs a flag bit is set to a "1" in Register A. Each of the three interrupt sources have separate flag bits in Register A, which are set independent of the state of the corresponding enable bits in Register B. The flag bit may be used with or without enabling the corresponding enable bits.

In the software scanned case, the program does not enable the interrupt. The "interrupt" flag bit becomes a status bit, which the software interrogates, when it wishes. When the software detects that the flag is set, it is an indication to software that the "interrupt" event occurred since the bit was last read.

However, there is one precaution. The flag bits in Register A are cleared (record of the interrupt event is erased) when Register A is read. Double latching is included with Register A so the bits which are set are stable throughout the read cycle. All bits which are high when read by the program are cleared, and new interrupts (on any bits) are held until after the read cycle. One, two, or three flag bits may be found to be set when Register A is read. The program should inspect all utilized flag bits every time. Register A is read to insure that no interrupts are lost.

The second flag bit usage method is with fully enabled interrupts. When an interrupt-flag bit is set and the corresponding interrupt-enable bit is also set, the $\overline{\text{IRO}}$ pin is asserted low $\overline{\text{IRO}}$ is asserted as long as at least one of the three interrupt sources has its flag and enable bits both set. The IRQF bit in Register A is a "1" whenever the $\overline{\text{IRO}}$ pin is being driven low

The processor program can determine that the RTC initiated the interrupt by reading Register A. A "1" in bit 7 (IRQF bit) indicates that one or more interrupts have been initiated by the part. The act of reading Register A clears all the then-active flag bits, plus the IRQF bit. When the program finds IRQF set, it should look at each of the individual flag bits in the same byte which have the corresponding interrupt-mask bits set and service each interrupt which is set. Again, more than one interrupt-flag bit may be set.

DIVIDER STAGES

The MC146818 has 22 binary-divider stages following the time base as shown in Figure 1. The output of the dividers is a 1 Hz signal to the update-cycle logic. The dividers are controller by three divider bus (DV2, DV1, and DV0) in Register A

DIVIDER CONTROL

The divider-control bits have three uses, as shown in Table 4. Three usable operating time bases may be selected (4.194304 MHz, 1.048576 MHz, or 32.768 kHz). The divider chain may be held reset, which allows precision setting of the time. When the divider is changed from reset to an operating time base, the first update cycle is one second later. The divider-control bits are also used to facilitate testing the MC146818.

TABLE 4 - DIVIDER CONFIGURATIONS

| Time-Base Frequency | Divider Bits Register A | | | Operation Mode | Divider Reset | Bypass First N-Divider Bits | |
|------------------------|----------------------------|-----|-----|-------------------|------------------|--------------------------------|--|
| | DV2 | DV1 | DV0 | | | | |
| 4 194304 MHz | 0 | 0 | 0 | Yes | - | N = 0 | |
| 1 048576 MHz | 0 | 0 0 | | Yes | _ | N = 2 | |
| 32 768 kHz | 0 | 1 | 0 | Yes | - | N = 7 | |
| Any | 1 | 1 | 0 | No | Yes | | |
| Any | 1 | 1 | 1 | No | Yes | _ | |

Note. Other combinations of divider bits are used for test purposes only

SQUARE-WAVE OUTPUT SELECTION

Fifteen of the 22 divider taps are made available to a 1-of-15 selector as shown in Figure 1. The first purpose of selecting a divider tap is to generate a square-wave output signal in the SQW pin. Four bits in Register A establish the square-wave frequency as listed in Table 5. The SQW frequency selection shares the 1-of-15 selector with periodic interrupts.

Once the frequency is selected, the output of the SQW pin may be turned on and off under program control with the square-wave enable (SQWE) bit in Register B. Altering the divider, square-wave output selection bits, or the SQW output-enable bit may generate an asymetrical waveform at the time of execution. The square-wave output pin has a number of potential uses. For example, it can serve as a frequency standard for external use, a frequency synthesizer, or could be used to generate one or more audio tones under program control

PERIODIC INTERRUPT SELECTION

The periodic interrupt allows the \overline{IRQ} pin to be triggered from once every 500 ms to once every 30.517 μ s. The periodic interrupt is separate from the alarm interrupt which may be output from once-per-second to once-per-day.

Table 5 shows that the periodic interrupt rate is selected with the same Register A bits which select the square-wave frequency. Changing one also changes the other. But each function may be separately enabled so that a program could switch between the two features or use both. The SQW pin is enabled by the SQWE bit. Similarly the periodic interrupt is enabled by the PIE bit in Register B.

Periodic interrupt is usable by practically all real-time systems. It can be used to scan for all forms of inputs from contact closures to serial receive bits or tyes. It can be used in multiplexing displays or with software counters to measure inputs, create output intervals, or await the next needed software function.

TABLE 5 - PERIODIC INTERRUPT RATE AND SQUARE WAVE OUTPUT FREQUENCY

| | D-4- | Select | | | .048576 MHz Base | 32.768 kHz Time Base | | | |
|-----|------|----------|-----|---|-------------------------|---|-------------------------|--|--|
| RS3 | | Register | RS0 | Periodic Interrupt Rate tp _l | SQW Output Frequency | Periodic Interrupt Rate ^t PI | SQW Output Frequency | | |
| 0 | 0 | 0 | 0 | None | None | None | None | | |
| 0 | 0 | . 0 | 1 | 30 517 μs | 32 768 kHz | 3 90625 ms | 256 Hz | | |
| 0 | 0 | 1 | 0 | 61 035 μs | 16 384 kHz | 7 8125 ms | 128 Hz | | |
| 0 | 0 | 1 | 1 | 122 070 µs | 8 192 kHz | 122 070 µs | 8 192 kHz | | |
| 0 | 1 | 0 | 0 | 244 141 µs | 4 096 kHz | 244 141 μs | 4 096 kHz | | |
| 0 | 1 | 0 | 1 | 488 281 µs | 2 048 kHz | 488 281 µs | 2 048 kHz | | |
| 0 | 1 | 1 | 0 | 976 562 μs | 1 024 kHz | 976 562 μs | 1 024 kHz | | |
| 0 | 1 | 1 | 1 | 1 953125 ms | 512 Hz | 1 953125 ms | 512 Hz | | |
| 1 | 0 | 0 | 0 | 3 90625 ms | 256 Hz | 3 90625 ms | 256 Hz | | |
| 1 | 0 | 0 | 1 | 7 8125 ms | 128 Hz | 7 8125 ms | 128 Hz | | |
| 1 | 0 | 1 | 0 | 15 625 ms | 64 Hz | 15 625 ms | 64 Hz | | |
| 1 | 0 | 1 | 1 | 31.25 ms | 32 Hz | 31.25 ms | 32 Hz | | |
| 1 | 1 | 0 | 0 | 62 5 ms | 16 Hz | 62 5 ms | 16 Hz | | |
| 1 | 1 | 0 | 1 | 125 ms | 8 Hz | 125 ms | 8 Hz | | |
| 1 | 1 | 1 | 0 | 250 ms | 4 Hz | -250 ms | 4 Hz | | |
| 1 | 1 | 1 | 1 | 500 ms | 2 Hz | 500 ms | 2 Hz | | |

UPDATE CYCLE

The MC146818 executes an update cycle once-persecond, assuming one of the proper time bases is in place, the divider is not clear, and the SET bit in Register B is clear. The SET bit in the "1" state permits the program to initialize the time and calendar bytes by stopping an existing update and preventing a new one from occurring

The primary function of the update cycle is to increment the seconds byte, check for overflow, increment the minutes byte when appropriate and so forth through to the year of the century byte. The update cycle also compares each alarm byte with the corresponding time byte and issues an alarm if a match or if a "don't care" code (11XXXXXX) is present in all three positions.

With a 4 194304 MHz or 1 048576 MHz time base the update cycle takes 248 μs while a 32 768 kHz time base update cycle takes 1984 μs During the update cycle, the time, calendar, and alarm bytes are not accessable by the processor program The MC146818 protects the program from reading transitional data. This protection is provided by switching the time, calendar, and alarm portion of the RAM off the microprocessor bus during the entire update cycle. If the processor reads these RAM locations before the update is complete the output will be undefined. The update in progress (UIP) status bit is set during the interval

A program which randomly accesses the time and date information finds data unavailable statistically once every 4032 attempts. Three methods of accommodating nonavailability during update are usable by the program. In discussing the three methods it is assumed that at random points user programs are able to call a subroutine to obtain the time of day

The first method of avoiding the update cycle uses the update-ended interrupt if enabled, an interrupt occurs after every update cycle which indicates that over 999 ms are available to read valid time and date information. During this time a display could be updated or the information could be transfered to continuously available RAM. Before leaving the interrupt service routine, the IRQF bit in Register C should be cleared.

The second method uses the update-in-progress bit (UIP) in Register B to determine if the update cycle is in progress or not. The UIP bit will pulse once-per-second. Statistically, the UIP bit will indicate that time and date information is unavailable once every 2032 attempts. After the UIP bit goes high, the update cycle begins 244 μ s later. Therefore, if a low is read on the UIP bit, the user has at least 244 μ s before the time/calendar data will be changed. If a "1" is read in the

UIP bit, the time/calendar data may not be valid. The user should avoid interrupt service routines that would cause the time needed to read valid time/calendar data to exceed 244 μ s

The third method uses a periodic interrupt to determine if an update cycle is in progress. The UIP bit in Register A is set high between the setting of the PF bit in Register C (see Figure 16). Periodic interrupts that occur at a rate of greater than $t_{BUC} + t_{UC}$ allow valid time and date information to be read at each occurrence of the periodic interrupt. The reads should be completed within $(T_{PI} + 2) + t_{BUC}$ to insure that data is not read during the update cycle.

REGISTERS

The MC146818 has four registers which are accessible to the processor program. The four registers are also fully accessible during the update cycle.

REGISTER A (\$0A)

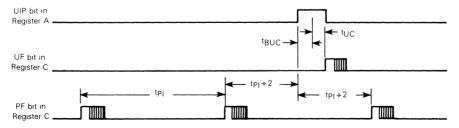
| Read/Write | LSB | | | | | | | MSB | |
|------------|-----|-----|-----|-----|-----|-----|-----|-----|--|
| Register | b0 | b1 | b2 | b3 | b4 | b5 | b6 | b7 | |
| except UIP | RS0 | RS1 | RS2 | RS3 | DV0 | DV1 | DV2 | UIP | |

 \mbox{UIP} — The update in progress (UIP) bit is a status flag that may be monitored by the program. When UIP is a ''1'' the update cycle is in progress or will soon begin. When UIP is a ''0'' the update cycle is not in progress and will not be for at least 244 μs (for all time bases). This is detailed in Table 6. The time, calendar, and alarm information in RAM is fully available to the program when the UIP bit is zero. — it is not in transition. The UIP bit is a read-only bit, and is not affected by Reset. Writing the SET bit in Register B to a ''1'' inhibit any update cycle and then clear the UIP status bit

TABLE 6 - UPDATE CYCLE TIMES

| UIP Bit | Time Base (OSC1) | Update Cycle Time (t _{UC}) | Minimum Time Before Update Cycle (tBUC) |
|---------|---------------------|---|---|
| 1 | 4 194304 MHz | 248 µs | - |
| 1 | 1 048576 MHz | 248 μs | _ |
| 1 | 32 768 kHz | 1984 μs | _ |
| 0 | 4 194304 MHz | | 244 μs |
| 0 | 1 048576 MHz | - | 244 μs |
| 0 | 32 768 kHz | - | 244 μs |

FIGURE 16 - UPDATE-ENDED AND PERIODIC INTERRUPT RELATIONSHIPS



tpi = Periodic Interrupt Time Interval (500 ms, 250 ms, 125 ms, 62 5 ms, etc.) tUC = Update Cycle Time (244 μ s)

tBUC = Delay Time Before Update Cycle (248 μs or 1984 μs)

DV2, DV1, DV0 — Three bits are used to permit the program to select various conditions of the 22-stage divider chain. The divider selection bits identify which of the three time-base frequencies is in use Table 4 shows that time bases of 4 194304 MHz, 1 048576 MHz, and 32 768 kHz may be used. The divider selection bits are also used to reset the divider chain. When the time/calendar is first initialized, the program may start the divider at the precise time stored in the RAM. When the divider reset is removed the first update cycle begins one second later. These three read/write bits are never modified by the RTC and are not affected by a second conditions.

RS3, RS2, RS1, RS0 — The four rate selection bits select one of 15 taps on the 22-stage divider, or disable the divider output. The tape selected may be used to generate an output square wave (SQW pin) and/or a periodic interrupt. The program may do one of the following. 1) enable the interrupt with the PIE bit, 2) enable the SQW output pin with the SQWE bit, 3) enable both at the same time at the same rate, or 4) enable neither. Table 5 lists the periodic interrupt rates and the square-wave frequencies that may be chosen with the RS bits. These four bits are read/write bits which are not affected by RESET and are never changed by the RTC

REGISTER B (\$0B)

| MSB | | | | | | | LSB | Read/Write |
|-----|-----|-----|-----|------|------------|-------|-----|------------|
| b7 | b6 | b5 | b4 | b3 | b 2 | b1 | b0 | Registe |
| SET | PIE | AIE | UIE | SQWE | DM | 24/12 | DSE | |

SET — When the SET bit is a "0", the update cycle functions normally by advancing the counts once-per-second. When the SET bit is written to a "1", any update cycle in progress is aborted and the program may initialize the time and calendar bytes without an update occurring in the midst of initializing SET is a read/write bit which is not modified by RESET or internal functions of the MC146818

PIE — The periodic interrupt enable (PIE) bit is a read/write bit which allows the periodic-interrupt flag (PF) bit to cause the $\overline{\text{IRQ}}$ pin to be driven low. A program writes a "1" to the PIE bit in order to receive periodic interrupts at the rate specified by the RS3, RS2, RS1, and RS0 bits in Control Register A. A zero in PIE blocks $\overline{\text{IRQ}}$ from being initiated by a periodic interrupt, but the periodic flag (PF) bit is still set at the periodic rate. PIE is not modified by any internal MC146818 functions, but is cleared to "0" by a RESET.

AlE — The alarm interrupt enable (AIE) bit is a read/write bit which when set to a "1" permits the alarm flag (AF) to assert $\overline{\text{IRO}}$. An alarm interrupt occurs for each second that the three time bytes equal the three alarm bytes (including a "don't care" alarm code of binary 11XXXXXX). When the AIE bit is a "0", the AF bit does not initiate an $\overline{\text{IRO}}$ signal. The $\overline{\text{RESET}}$ pin clears AIE to "0". The internal functions do not affect the AIE bit.

UIE — The UIE (update-ended interrupt enable) bit is a read/write bit which enables the update-end flage (UF) bit to assert IRQ. The RESET pin going low or the SET bit going high clears the UIE bit.

SQWE — When the square-wave enable (SQWE) bit is set to a "1" by the program, a square-wave signal at the fre-

quency specified in the rate selection bits (RS3 to RS0) appears on the SQW pin. When the SQWE bit is set to a zero the SQW pin is held low. The state of SQWE is cleared by the $\overline{\text{RESET}}$ pin. SQWE is a read/write bit.

DM — The data mode (DM) bit indicates whether time and calendar updates are to use binary or BCD formats. The DM bit is written by the processor program and may be read by the program, but is not modified by any internal functions or RESET. A "1" in DM signifies binary data, while a "0" in DM specifies binary-coded-decimal (BCD) data

24/12 — The 24/12 control bit establishes the format of the hours bytes as either the 24-hour mode (a "1") or the 12-hour mode (a "0"). This is a read/write bit, which is affected only by the software.

DSE — The daylight savings enable (DSE) bit is a read/write bit which allows the program to enable two special updates (when DSE is a "1") On the last Sunday in April the time increments from 1.59.59 AM to 3:00 00 AM On the last Sunday in October when the time first reaches 159 9AM it changes to 100 00 AM. These special updates do not occur when the DSE bit is a "0" DSE is not changed by any internal operations or reset

REGISTER C (\$0C)

| MSB LSB | | | | | | | Read-Only | |
|---------|----|----|----|----|---|----|-----------|----------|
| b7 | b6 | b5 | b4 | b3 | b | b1 | ь0 | Register |
| IRQF | PF | AF | UF | 0 | 0 | 0 | 0 | |

IRQF — The interrupt request flag (IRQF) is set to a "1" when one or more of the following are true

PF= PIE= "1"

AF= AIE= "1"

UF= UIE= "1"

I e , IRQF= PF• PIE+ AF• AIE+ UF• UIE

Any time the IRQF bit is a "1", the $\overline{\text{IRQ}}$ pin is driven low All flag bits are cleared after Register C is read by the program or when the $\overline{\text{RESET}}$ pin is low. A program write to Status Register 2 does not modify any of the flag bits

PF — The periodic interrupt flag (PF) is a read-only bit which is set to a "1" when a particular edge is detected on the selected tap of the divider chain. The RS3 to RS0 bits establish the periodic rate. PF is set to a "1" independent of the state of the PIE bit. PF being a "1" initiates an $\overline{\text{IRO}}$ signal and the IRQF bit when PIE is also a "1". The PF bit is cleared by a RESET or a software read of Register C

AF-A "1" in the AF (alarm interrupt flag) bit indicates that the current time has matched the alarm time. A "1" in the AF causes the $\overline{\mbox{IRQ}}$ pin to go low, and a "1" to appear in the IRQF bit, when the AIE bit also is a "1" A $\overline{\mbox{RESET}}$ or a read of Register C clears AF

UF- The update-ended interrupt flag (UF) bit is set after each update cycle. When the UIE bit is a "1", the "1" in UF causes the IRQF bit to be a "1", asserting $\overline{|RQ|}$ UF is cleared by a Register C read or a $\overline{\text{RESET}}.$

B3 TO B0 — The unused bits of Status Register 1 are read as "0's". They can not be written.

REGISTER D (\$0D)

| | LSB | | | MSB | | | | | |
|-----------|-----|----|----|-----|----|------------|----|-----|--|
| Read Only | b0 | b1 | b2 | b3 | b4 | b 5 | b6 | b7 | |
| Register | 0 | 0 | 0 | 0 | 0 | 0 | 0 | VRT | |

VRT — The valid RAM and time (VRT) bit indicates the condition of the contents of the RAM, provided the power sense (PS) pin is satisfactorily connected. A "0" appears in the VRT bit when the power-sense pin is low. The processor program can set the VRT bit when the time and calendar are initialized to indicate that the RAM and time are valid. The VRT is a read/only bit which is not modified by the RESET pin. The VRT bit can only be set by reading the Register D.

b6 TO b0 — The remaining bits of Register D are unused They cannot be written, but are always read as "0's"

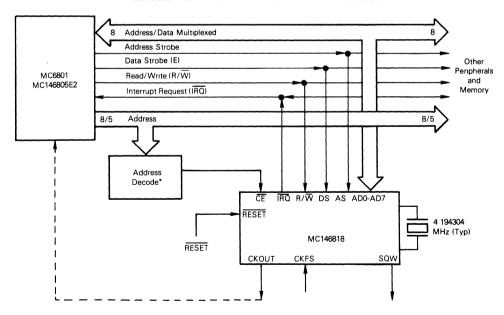
TYPICAL INTERFACING

The MC146818 is best suited for use with microprocessors which generate an address-then-data multiplexed bus Figures 17 and 18 show typical interfaces to bus-compatible processors. These interfaces assume that the address decoding can be done quickly. However, if standard metalgate CMOS gates are used the CE setup time may be violated. Figure 19 illustrates an alternative method of chip selection which will accommodate such slower decoding.

The MC146818 can be interfaced to single-chip microcomputers (MCU) by using eleven port lines as shown in Figure 20. Non-multiplexed bus microprocessors can be interfaced with additional support.

There are two methods of using the multiplexed bus MC146818 with non-multiplexed bus processors. The first method uses available bus control signals to multiplex the address and data bus together. An example using the MC68000 is shown in Figure 21. An octal non-inverting three-state buffer and an octal non-inverting bidirectional three-state buffer can be used to multiplex the MC68000 address and data bus for the MC146818. VMA is used for AS. therefore, VPA must be asserted. The second method uses software to load the address to the MC146818 via the data bus. The hardware for this method is shown in Figures 22. and 23 Table 7 lists the software used for the Motorola compatible bus microprocessors Software for other compatible microprocessors is listed in Table 8. In either case, the MC146818 multiplexed bus is connected only to the MPU's data bus. The register address is written into the MC146818 using an even-address location. Data can then be written or read when the MC146818 is selected and A0 is high (odd address) CE is shown tied to VSS since the latched address is lost when CE is brought high. The decoded address for selecting the MC146818 will not remain valid between generation of AS and DS unless a flip-flop is used

FIGURE 17 — MC146818 INTERFACED TO MOTOROLA COMPATIBLE MULTIPLEXED BUS MICROPROCESSORS



^{*}High-Speed Silicon-Gate CMOS or TTL Address Decoding

FIGURE 18 — MC146818 INTERFACED TO COMPETITOR COMPATIBLE MULTIPLEXED BUS MICROPROCESSORS

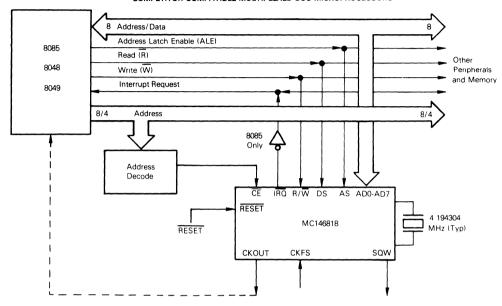
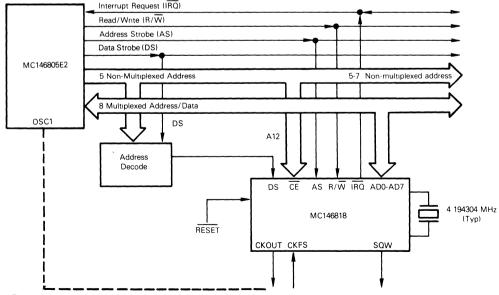


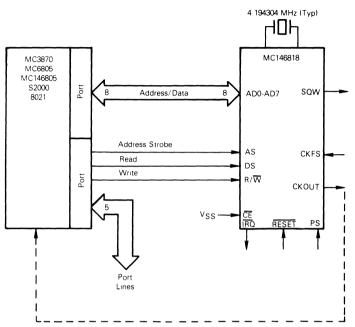
FIGURE 19 — MC146818 INTERFACE TO MC146805E2
CMOS MULTIPLEXED MICROPROCESSOR WITH SLOW ADDRESSING DECODING



This illustrates the use of CMOS gating for address decoding

4-1063

FIGURE 20 — MC146818 INTERFACED WITH THE PORTS OF A TYPICAL SINGLE CHIP MICROCOMPUTER



VPA AS Address A1-A23 Address Decode v_{DD} to 4 194304 MHz **A8** (Typ) Ε Open Octal Collector Noninverting Three-State ŌĒ Buffer ĈĒ (74LS240) AD0-AD7 MC68000 Octal ŌĒ Noninverting Bidirectional Three-State DR MC146818 Buffer (74LS245) D0-D7 R/W R/\overline{W} $\overline{\mathsf{VMA}}$ AS Ε ĪRQ 8-3 IPL0-IPL2 Encoder

FIGURE 21 - MC68000 INTERFACE

TABLE 7 — SOFTWARE FOR MOTOROLA NON-MULTIPLEXED BUS MICROPROCESSORS

| * | ACCUMULATOR A ACCUMULATOR B | | DATA ·MC146814 byte to be addressed | | |
|---|-----------------------------|---------------------|--|----------------|-----------------|
| | RTC | EQU | \$B000 | | |
| | PUT | STAB STAA RTS | RTC RTC+1 | LATCH STORE | ADDRESS DATA |
| | GET | STAB LDAA RTS | RTC RTC+1 | LATCH READ | ADDRESS DATA |

TABLE 8 — SOFTWARE FOR OTHER NON-MULTIPLEXED BUS MICROPROCESSORS

| PUT | LD LD RET | RTC,B RTC+1,A |
|-----|-----------------|-------------------|
| GET | LD LD RET | RTC,B A, RTC+1 |



MC146823

Product Preview

CMOS PARALLEL INTERFACE

The CMOS MC146823 Parallel Interface (PI) provides a universal means of interfacing external signals with the MC146805E2 CMOS microprocessor, and other multiplexed bus microprocessors. The unique MOTEL circuit on-chip allows direct interfacing to most industry CMOS microprocessors, as well as many NMOS MPUs

The MC14823 PI includes three bidirectional 8-bit ports, or 24 I/O pins. Each I/O line may be separately established as an input or an output under program control via data direction registers associated with each port Using the bit change and test instructions of the MC146805E2, each individual I/O pin can be separately accessed. All port registers are read/write bytes to accommodate read/modify/write instructions.

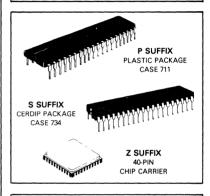
- 24 Individual Programmed I/O Pins
- MOTEL Circuit for Bus Compatibility with Many Microprocessors
- Multiplexed Bus Compatible with. MC146805E2, MC6801, MC6803 and Competitive Microprocessors
- Data Direction Registers for Ports A, B, and C
- Port C may also be Control Lines for Four Interrupt Inputs Input Byte Latch Output Pulse
- 16 Registers Addressed as Memory Locations
- Handshake Control Logic for Input and Output Peripheral Operation
- Interrupt Output Pin
- Reset Input to Clear Interrupts and Initialize Internal Registers
- 40-Pin Package

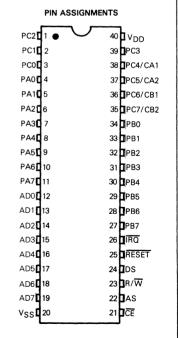
MC146823 PARALLEL INTERFACE CMOS Microprocessor 20-to-24 Port Bus Mux Bidirectional 16 Addressable Bus 1/0 Bytes Por Bus 4 Cont В Port 4 to 8 С 3 to 6 V 0-to-4 Port Control Port ĪRQ and/or 0 to 4 Interrupt Interrupt Cont RESET Interrupts Control 40 Pins

CMOS

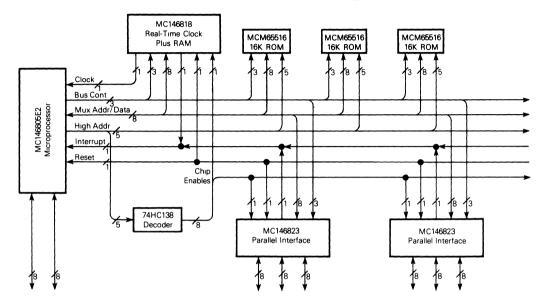
(HIGH-DENSITY HIGH-PERFORMANCE SILICON-GATE)

PARALLEL INTERFACE





A TYPICAL CMOS MICROPROCESSOR SYSTEM



An 8-Chip CMOS Microprocessor System Includes Powerful 8-Bit Processor 6K Bytes of ROM 162 Bytes of RAM

64 Parallel I/O Pins

Up to 12 System Interrupts
Timer Interrupt
Periodic Interrupt
Alarm Time Interrupt
Update Cycle (1 Second) Interrupt
Up to 8 External Event Interrupts
Time-Of-Day and Calendar
8-Bit Programmable Counter with 7-Bit Prescaler

Four of the 24 I/O pins have multiple functions. The mode of these four lines is selected by programming the Port C Pin Function Select Register. Any of the four control pins may be configured to initiate interrupts to the microprocessor via the $\overline{\mbox{IRO}}$ pin. All four interrupts have separate programmable enables, status bits, methods of clearing the interrupt, and over-run detection.

The interrupts are enabled and the port handshaking controls are established via the content of Control Registers associated with Ports A and \underline{B} . The interrupt conditions are indicated in a Status Register and the IRQ pin is asserted. The interrupts are normally cleared by reading or writing the associated port data. Ports A and B each have three addresses for reading/writing data. Two addresses access the data and clear an interrupt while the third accesses the data without modifying the interrupt status.

MC146823 Registers

| 0 | Port A Data, Clear CA1 Interrupt |
|---|---|
| 1 | Port A Data, Clear CA2 Interrupt |
| 2 | Port A Data |
| 3 | Port B Data |
| 4 | Port C Data |
| 5 | Not Used |
| 6 | Data Direction Register for Port A |
| 7 | Data Direction Register for Port B |
| 8 | Data Direction Register for Port C |
| 9 | Control Register for Port A |
| Α | Control Register for Port B |
| В | Pin Function Select Register for Port C |
| С | Port B Data, Clear CB1 Interrupt |
| D | Port B Data, Clear CB2 Interrupt |
| Е | Interrupt Status Register |
| F | Interrupt Over-Run Warning Register |

L

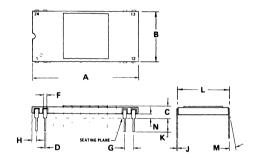
Mechanical Data

MECHANICAL DATA

The package availability for each device is indicated on the front page of the individual data sheets. Dimensions for the packages are given in this chapter.

24-PIN PACKAGES

CERAMIC PACKAGE CASE 716



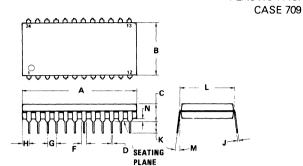


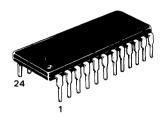
NOTE:

- LEADS TRUE POSITIONED WITHIN
 0.25mm (0.010) DIA (AT SEATING
 PLANE) AT MAXIMUM MATERIAL
 CONDITION.
- 2. DIM "L" TO CENTER OF LEADS WHEN FORMED PARALLEL.

| | MILLIN | METERS | INC | HES | | |
|-----|--------|--------|-----------|-------|--|--|
| DIM | MIN | MAX | MIN | MAX | | |
| Α | 27.64 | 30 99 | 1.088 | 1.220 | | |
| В | 14.73 | 15.34 | 0.580 | 0.604 | | |
| C | 2.67 | 4.32 | 0.105 | 0.170 | | |
| D | 0.38 | 0.53 | 0.015 | 0.021 | | |
| F | 0.76 | 1.40 | 0.030 | 0.055 | | |
| G | 2.54 | BSC | 0,100 BSC | | | |
| Н | 0.76 | 1.78 | 0.030 | 0.070 | | |
| J | 0.20 | 0.30 | 0.008 | 0.012 | | |
| K | 2.54 | 4.57 | 0.100 | 0.180 | | |
| L | 14.99 | 15.49 | 0.590 | 0.610 | | |
| M | _ | 100 | - | 100 | | |
| N | 1.02 | 1.52 | 0.040 | 0.060 | | |

■ 24-PIN PACKAGES (CONTINUED) PLASTIC PACKAGE



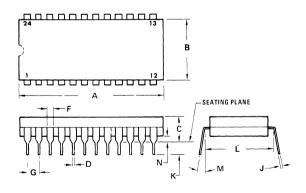


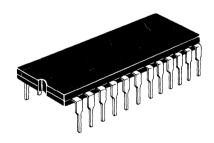
MILLIMETERS INCHES MIN MAX DIM MIN MAX 31.37 32.13 1.235 1.265 31.37 32.13 1.259 1.269 13.72 14.22 0.540 0.560 3 94 5.08 0.155 0 200 0.36 0.56 0.014 0.022 1.02 1.52 0.040 0.060 2.54 2.52 0.000 0.000 2.54 BSC G 0.100 BSC 1 78 2.03 0.20 0.38 0.070 0.080 0.008 0.015 2.92 3.43 15.24 BSC 00 150 0.115 0.135 0.600 BSC 00 150 0.51 1.02 0.020 0.040

NOTES:

- 1. POSITIONAL TOLERANCE OF LEADS (D), SHALL BE WITHIN 0.25 mm (0.010) AT MAXIMUM MATERIAL CONDITION, IN RELATION TO SEATING PLANE AND EACH OTHER.
- 2. DIMENSION L TO CENTER OF LEADS · WHEN FORMED PARALLEL.
- 3. DIMENSION B DOES NOT INCLUDE MOLD FLASH.

CERDIP PACKAGE **CASE 623**





MILLIMETERS

NOTES:

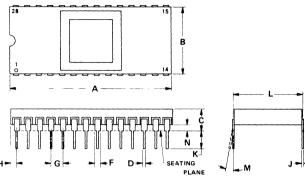
- 1. DIM "L" TO CENTER OF LEADS WHEN FORMED PARALLEL.
- 2. LEADS WITHIN 0.13 mm (0.005) RADIUS OF TRUE POSITION AT SEATING PLANE AT MAXIMUM MATERIAL CONDITION. (WHEN FORMED PARALLEL)

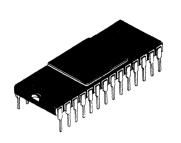
| DIM | MIN | MAX | MIN | MAX |
|-----|-------|-------|-----------|-----------------|
| Α | 31.24 | 32 77 | 1.230 | 1.290 |
| В | 12 70 | 15 49 | 0.500 | 0 610 |
| C | 4 06 | 5.59 | 0.160 | 0 220 |
| D | 0.41 | 0 51 | 0.016 | 0.020 |
| F | 1.27 | 1.52 | 0.050 | 0 060 |
| G | 2.54 | BSC | 0.100 BSC | |
| J | 0.20 | 0.30 | 0.008 | 0.012 |
| K | 2.29 | 4.06 | 0 090 | 0.160 |
| L | 15 2 | 4 BSC | 0.600 |) BSC |
| M | 00 | 150 | 00 | 15 ⁰ |
| N | 0.51 | 1 27 | 0.020 | 0.050 |

INCHES

=28-PIN PACKAGES=

CERAMIC PACKAGE CASE 719



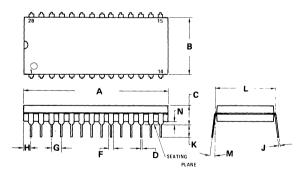


| | MILLIN | IETERS | INCHES | |
|-----|--------|--------|-----------|-------|
| DIM | MIN | MAX | MIN | MAX |
| A | 35 20 | 35.92 | 1.386 | 1.414 |
| В | 14 73 | 15.34 | 0.580 | 0.604 |
| C | 3.05 | 4.19 | 0.120 | 0.165 |
| D | 0.38 | 0.53 | 0.015 | 0.021 |
| F | 0.76 | 1.40 | 0.030 | 0.055 |
| G | 2.54 | BSC | 0.100 BSC | |
| H | 0.76 | 1.78 | 0.030 | 0.070 |
| J | 0.20 | 0.30 | 0.008 | 0.012 |
| K | 2.54 | 4.19 | 0.100 | 0.165 |
| L | 14.99 | 15.49 | 0.590 | 0.610 |
| M | - | 100 | _ | 100 |
| N | 0.51 | 1.52 | 0.020 | 0.060 |

NOTES

- 1. LEADS, TRUE POSITIONED WITHIN 0.25 mm (0.010) DIAMETER (AT SEATING PLANE) AT MAXIMUM MATERIAL CONDITION.
- 2 DIMENSION "L" TO CENTER OF LEADS WHEN FORMED PARALLEL.

PLASTIC PACKAGE CASE 710

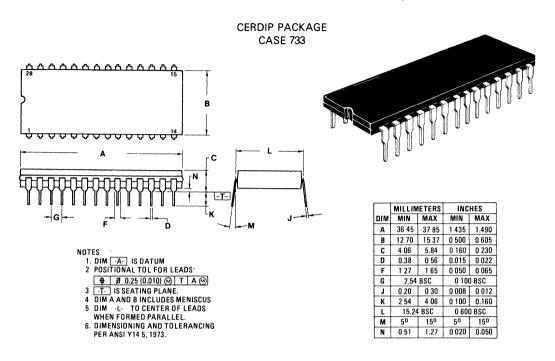


NOTES:

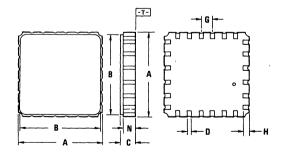
- 1. POSITIONAL TOLERANCE OF LEADS (D), SHALL BE WITHIN 0.25mm(0.010) AT MAXIMUM MATERIAL CONDITION, IN RELATION TO SEATING PLANE AND EACH OTHER.
- 2. DIMENSION L TO CENTER OF LEADS WHEN FORMED PARALLEL.
- 3. DIMENSION B DOES NOT INCLUDE MOLD FLASH.

| | MILLIN | ETERS | INCHES | | |
|-----|--------|-----------------|--------|-----------------|--|
| DIM | MIN | MAX | MIN | MAX | |
| Α | 36.45 | 37.21 | 1.435 | 1.465 | |
| В | 13.72 | 14.22 | 0.540 | 0.560 | |
| C | 3.94 | 5.08 | 0.155 | 0.200 | |
| D | 0.36 | 0.56 | 0.014 | 0.022 | |
| F | 1.02 | 1.52 | 0.040 | 0.060 | |
| G | 2.54 | BSC | 0.100 | BSC | |
| Н | 1.65 | 2.16 | 0.065 | 0.085 | |
| J | 0.20 | 0.38 | 0.008 | 0.015 | |
| K | 2.92 | 3.43 | 0.115 | 0.135 | |
| L | 15.24 | BSC | 0.600 | BSC | |
| M | 00 | 15 ⁰ | 00 | 15 ⁰ | |
| N | 0.51 | 1.02 | 0.020 | 0.040 | |

28-PIN PACKAGES (CONTINUED)



CHIP CARRIER CASE 753





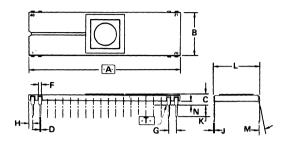
NOTES:

- 1. DIMENSION A IS DATUM. (2 PLACES)
- 2. T. IS GUAGE PLANE.
- 3. POSITIONAL TOLERANCE
 FOR TERMINALS (D): 24 PLACES

| | MILLIN | IETERS | S INCHES | |
|-----|----------|--------|----------|-------|
| DIM | MIN | MAX | MIN | MAX |
| Α | 9.91 | 10.41 | 0.390 | 0.410 |
| В | 9.78 | 9.90 | 0.385 | 0.390 |
| С | 1.63 | 1.93 | 0.064 | 0.076 |
| D | 0.39 | 0.63 | 0.015 | 0.025 |
| G | 1.27 BSC | | 0.050 | BSC |
| Н | 0.77 | 1.01 | 0.030 | 0.040 |
| N | 1.40 | 1.65 | 0.055 | 0.065 |

40-PIN PACKAGES

CERAMIC PACKAGE CASE 715



| White State of the state of the |
|--|
|--|

| | MILLIM | ETERS | INCHES | |
|-----|--------|-------|-----------|-------|
| DIM | MIN | MAX | MIN | MAX |
| Α | 50.29 | 51.31 | 1.980 | 2 020 |
| В | 14.63 | 15.49 | 0.576 | 0.610 |
| C | 3.18 | 5.08 | 0.125 | 0.200 |
| D | 0.38 | 0.53 | 0.015 | 0.021 |
| F | 0.76 | 1.52 | 0.030 | 0.060 |
| G | 254 | BSC | 0.100 BSC | |
| J | 0.20 | 0.33 | 0.008 | 0.013 |
| K | 2.54 | 4.57 | 0.100 | 0.180 |
| L | 14.99 | 15.65 | 0.590 | 0.616 |
| M | _ | 100 | - | 100 |
| N | 1.02 | 1.52 | 0.040 | 0.060 |

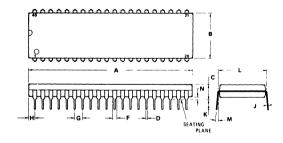
NOTES:

- 1. DIMENSION -A- IS DATUM
- 2. POSITIONAL TOLERANCE FOR LEADS:

⊕ 0.25 (0.010) **⊚ T A⊚**

- 3. T- IS SEATING PLANE.
- 4. DIMENSION "L" TO CENTER OF LEADS WHEN FORMED PARALLEL.
- 5. DIMENSIONING AND TOLERANCING PER ANSI Y14.5, 1973.

PLASTIC PACKAGE **CASE 711**



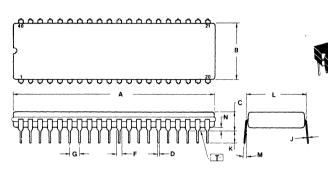


- 1. POSITIONAL TOLERANCE OF LEADS (D), SHALL BE WITHIN 0.25 mm (0.010) AT MAXIMUM MATERIAL CONDITION, IN RELATION TO SEATING PLANE AND EACH OTHER.
- 2. DIMENSION L TO CENTER OF LEADS WHEN FORMED PARALLEL.
- 3. DIMENSION B DOES NOT INCLUDE MOLD FLASH.

| | MILLIMETERS | | INCHES | |
|-----|-------------|-------|-----------|-------|
| DIM | MIN | MAX | MIN | MAX |
| Α | 51.69 | 52 45 | 2.035 | 2.065 |
| В | 13.72 | 14.22 | 0.540 | 0.560 |
| C | 3.94 | 5.08 | 0.155 | 0.200 |
| D | 0.36 | 0.56 | 0.014 | 0 022 |
| F | 1.02 | 1.52 | 0.040 | 0.060 |
| G | 2.54 BSC | | 0.100 BSC | |
| H | 1.65 | 2.16 | 0.065 | 0.085 |
| J | 0.20 | 0 38 | 0.008 | 0.015 |
| K | 2.92 | 3.43 | 0.115 | 0 135 |
| L | 15.24 BSC | | 0.600 BSC | |
| M | 00 | 150 | θo | 150 |
| N | 0.51 | 1.02 | 0.020 | 0.040 |

40-PIN PACKAGES (CONTINUED)

CERDIP PACKAGE CASE 734

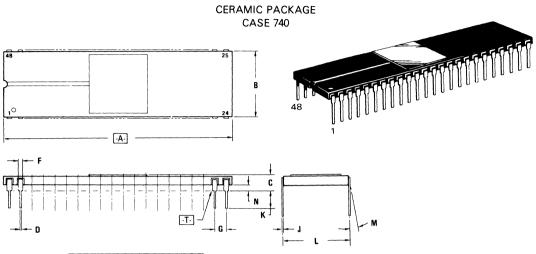




- 1 DIM -A- IS DATUM
- 2 POSITIONAL TOLERANCE FOR LEADS
- ♦ Ø 0.25(0.010) M T A M
- 3 T- IS SEATING PLANE.
- 4 DIM L TO CENTER OF LEADS WHEN FORMED PARALLEL
- 5 DIMENSIONS A AND B INCLUDE MENISCUS.
- 6 DIMENSIONING AND TOLERANCING PER ANSI Y14 5, 1973

| | MILLIMETERS | | INCHES | |
|-----|-------------|-----------------|-----------|-----------------|
| DIM | MIN | MAX | MIN | MAX |
| Α | 51.31 | 53.24 | 2.020 | 2.096 |
| В | 12 70 | 15.49 | 0 500 | 0.610 |
| C | 4 06 | 5 84 | 0.160 | 0.230 |
| D | 0.38 | 0.56 | 0 015 | 0 022 |
| F | 1 27 | 1.65 | 0 050 | 0 065 |
| G | 2.54 BSC | | 0 100 BSC | |
| J | 0 20 | 0.30 | 0.008 | 0 012 |
| K | 3 18 | 4 06 | 0 125 | 0.160 |
| L | 15 24 BSC | | 0 600 BSC | |
| Mi | 50 | 15 ⁰ | 50 | 15 ⁰ |
| N | 0.51 | 1 27 | 0 020 | 0.050 |

48-PIN PACKAGES



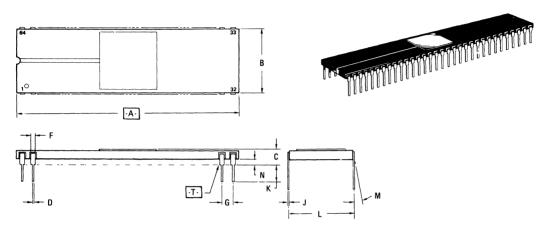
| | MILLIMETERS | | INCHES | |
|-----|-------------|-------|-----------|-------|
| DIM | MIN | MAX | MIN | MAX |
| Α | 60.35 | 61.57 | 2.376 | 2.424 |
| В | 14.63 | 15.34 | 0.576 | 0.604 |
| C | 3.05 | 4.32 | 0.120 | 0.160 |
| D | 0.381 | 0.533 | 0.015 | 0.021 |
| F | 0.762 | 1.397 | 0.030 | 0.055 |
| G | 2.54 BSC | | 0.100 BSC | |
| J | 0.203 | 0.330 | 0.008 | 0.013 |
| K | 2.54 | 4.19 | 0.100 | 0.165 |
| L | 14.99 | 15.65 | 0.590 | 0.616 |
| М | 00 | 100 | 00 | 100 |
| N | 1.016 | 1.524 | 0.040 | 0.060 |

NOTES:

- 1. DIMENSION A IS DATUM.
 2. POSTIONAL TOLERANCE FOR LEADS:
 - **♦** Ø 0.25 (0.010) T A
- 3. T. IS SEATING PLANE.
 4. DIMENSION "L" TO CENTER OF LEADS
 WHEN FORMED PARALLEL.
 5. DIMENSIONING AND TOLERANCING PER
- ANSI Y14.5, 1973.

= 64-PIN PACKAGES ==

CERAMIC PACKAGE CASE 746



NOTES.

- 1. DIMENSION .A. IS DATUM.
- 2. POSITIONAL TOLERANCE FOR LEADS:

 (0.25 (0.010) T A (
- 3. To IS SEATING PLANE.
- 4. DIMENSION "L" TO CENTER OF LEADS WHEN FORMED PARALLEL.
- 5. DIMENSIONING AND TOLERANCING PER ANSI Y14.5, 1973.

| | MILLIMETERS | | INCHES | |
|-----|-------------|-------|-----------|-------|
| DIM | MIN | MAX | MIN | MAX |
| Α | 80.52 | 82.04 | 3.170 | 3.230 |
| В | 22.25 | 22.96 | 0.876 | 0.904 |
| C | 3.05 | 4,32 | 0.120 | 0.170 |
| D | 0.38 | 0.53 | 0.015 | 0.021 |
| F | 0.76 | 1.40 | 0.030 | 0.055 |
| G | 2.54 BSC | | 0.100 BSC | |
| J | 0.20 | 0.33 | 0.008 | 0.013 |
| K | 2.54 | 4.19 | 0.100 | 0.165 |
| L | 22.61 | 23.11 | 0.890 | 0.910 |
| M | _ | 100 | _ | 100 |
| N | 1.02 | 1.52 | 0.040 | 0.060 |

6

Technical Training

TECHNICAL TRAINING SYSTEM DESIGN

Since 1974 when Motorola first introduced the M6800 Family course around the United States, Motorola technical training courses have been among the most popular and effective methods for system designers to catch up or keep up with the microprocessor/microcomputer state-of-the-art.

Motorola technical training courses are scheduled throughout the world with courses in the United States, Canada, Mexico, Europe, and Asia. The schedule is advertised periodically, and information is always available from the training headquarters in Phoenix.

A special session of any Motorola technical training course may be held at your facility. This can be a standard course or a course designed to fulfill your particular needs.

The following is a list of course offerings. For more detailed course descriptions, course schedule in your area, or enrollment procedures, write: Motorola Technical Training, P.O. Box 2953, Mail Drop TOM-57, Phoenix, Az. 85062. Or call 602-962-2345 or 602-244-4945.

COURSE OFFERINGS

Basic MC6800 Course — 4 Days (MTT1):

Course covers the MC6800 Microprocessor, Instruction Set, RAMs, ROMs, Addressing Modes, Assembler, PIA and ACIA, and example programs for the MC6800.

Basic M6801 Family — 2 Days (MTT2):

Course covers the MC6801 Microcomputer, Instruction Set, RAMs, ROMs, Addressing Modes, Assembler and Input/Output Techniques, and example programs for the MC6801.

MC6809 Update — 2 Days (MTT3):

Course covers MC6809 Microprocessor, Instruction Set, Addressing Modes, Relocatable Macro Assembler, and example programs for the MC6809.

High-Level Software — 4 Days (MTT4):

This high-level software course generates a working knowledge of the resident software packages available to users of EXORciser-based MDOS systems.

Software covered are Pascal, MPL, Fortran, Macro Assembler, and Linking Loader.

MC6801 Update — 1 Day (MTT5):

This course is an update course for students who are familiar with the MC6800 and need to be knowledgeable of the MC6801 Microcomputer.

M6805 Family Basic Course — 2 Day (MTT6):

This course covers the M6805 Family, the Instruction Set, RAMs, ROMs, Addressing Modes, Assembler, and example programs for the M6805 Family.

Understanding Microprocessor Basics — 1 Day (MTT7):

This course is a one-day non-technical course designed to acquaint Managers, Secretaries, Buyers, Salesmen, and other non-designers with microprocessors. We cover the whys, whats, and hows of microcomputer systems. We'll give you the buzz words and use simplified examples to explain basic concepts. It's a good non-technical course. If you understand terms such as data bus, interrupt, multiplexing, mnemonics, etc., then this course isn't for you.

MC68000 Microprocessor — 4 Day (MTT8):

General features of the processor, such as Pin Features, Registers, Address Modes, and Instruction Sets are covered. Attention is directed to unique features such as High-Level Software Instructions, Multiprocessor Capability, and Exception Processing. In addition, development tools including the Assembler, Editor, and MC68000 Design Module are discussed. Lab time helps provide experience.

Micromodules — 2 Days (MTT9):

This course is designed to develop an understanding of the board-level computer system design approach for potential Micromodule users. The theme of the course is "Learning the use of Micromodules through Examples."

Development Systems — 2 Day (MTT10):

This course is designed to prepare the student to understand and use the basic functions of the MC6800 and MC6809 development systems. Topics covered are EXORterm, EXORciser II, EXORdisk, System Analyzer, Usec, PROM Programmer, CRT Editor, Macro Assembler, Linking Loader, and Application Examples.

Basic MC6809 Course — 4 Days (MTT11):

This is a beginning course on microprocessors based on the powerful MC6809 hardware and software. It is very similar to course MTT1, but focuses on the MC6809 rather than the MC6800.

Pascal — 4 Days (MTT12):

This course is designed to enable even the novice programmer to write well-constructed programs in Pascal. The first three days are for illustration of standard Pascal and structured programming as taught in a college-level course. The fourth day includes Motorola extensions and implementations for the MC6809 and MC68000. Each student has the opportunity to complete and execute several programs. Each receives, and keeps, a home lab diskette with sample exercises.

EXORMacs — 2 Days (MTT13):

This course aids the student in becoming familiar with EXORmacs. Included are the use of Utilities, Assemblers, Editors/Debuggers, and how to use Pascal on EXORmacs.

MPL — 4 Days (MTT14):

This four day course provides detailed instructions and examples on how to program in MPL.

6

7

Memory Products

MEMORY PRODUCTS

Motorola has developed a very comprehensive range of reliable MOS and bipolar memory products for virtually any digital data processing system application.

The following selector guide lists the currently available MOS memory products, as of August 1981. Refer to the Motorola Memory Data Manual or the individual data sheet for the latest information on memory devices you wish to use.

The Memory Data Manual and individual data sheets may be obtained from distributors, Motorola sales offices, or by writing to:

Motorola Semiconductor Products, Inc. Literature Distribution Center P.O. Box 20924 Phoenix, Az. 85036

RAMS MOS DYNAMIC RAMS

| | | Access Time | Power | No. of |
|--------------|-------------------------|-------------|------------|--------|
| Organization | Part Number | (ns max) | Supplies | Pins |
| 4096 × 1 | MCM4027AC-2 | 150 | + 12, ±5 V | 16 |
| 4096 × 1 | MCM4027AC-3 | 200 | + 12, ±5 V | 16 |
| 4096 × 1 | MCM4027AC-4 | 250 | + 12, ±5 V | 16 |
| 16384 × 1 | MCM4116BP15 | 150 | + 12, ±5 V | 16 |
| 16384 × 1 | MCM4116BP20 | 200 | + 12, ±5 V | 16 |
| 16384 × 1 | MCM4116BP25 | 250 | +12, ±5 V | 16 |
| 16384 × 1 | MCM4517P10 | 100 | +5 V | 16 |
| 16384 × 1 | MCM4517P12 | 120 | +5 V | 16 |
| 16384 × 1 | MCM4517P15 | 150 | +5 V | 16 |
| 16384 × 1 | MCM4517P20 | 200 | +5 V | 16 |
| 32768 × 1 | MCM6632L15 ¹ | 150 | +5 V | 16 |
| 32768 × 1 | MCM6632L201 | 200 | +5 V | 16 |
| 32768 × 1 | MCM6632L251 | 250 | +5 V | 16 |
| 32768 × 1 | MCM6633L15 | 150 | +5 V | 16 |
| 32768 × 1 | MCM6633L20 | 200 | +5 V | 16 |
| 32768 × 1 | MCM6633L25 | 250 | +5 V | 16 |
| 65536 × 1 | MCM6664L151 | 150 | +5 V | 16 |
| 65536 × 1 | MCM6664L201 | 200 | +5 V | 16 |
| 65536 × 1 | MCM6664L251 | 250 | +5 V | 16 |
| 65536 × 1 | MCM6665L15 | 150 | +5 V | 16 |
| 65536 × 1 | MCM6665L20 | 200 | +5 V | 16 |
| 65536 × 1 | MCM6665L25 | 250 | +5 V | 16 |

MOS STATIC RAMs (+5 Volts)

| | | Access Time | No. of Pins 24 | |
|-----------------|---------------------------|-------------|----------------------|--|
| Organization | Part Number | (ns max) | | |
| 128 × 8 | MCM6810 | 450 | | |
| 128 × 8 | MCM68A10 | 360 | 24 | |
| 128 × 8 | MCM68B10 | 250 | 24 | |
| 1024 × 4 | MCM2114P20 | 200 | 18 | |
| 1024×4 | MCM2114P25 | 250 | 18 | |
| 1024×4 | MCM2114P30 | 300 | 18 | |
| 1024×4 | MCM2114P45 | 450 | 18 | |
| 1024×4 | MCM21L14P20 | 200 | 18 | |
| 1024×4 | MCM21L14P25 | 250 | 18 | |
| 1024×4 | MCM21L14P30 | 300 | 18 | |
| 1024 × 4 | MCM21L14P45 | 340 | 18 | |
| 1024 × 1 | MCM2115AC45 ² | 45 | 16 | |
| 1024×1 | MCM2115AC55 ² | 55 | 16 | |
| 1024×1 | MCM2115AC70 ² | 70 | 16 | |
| 1024×1 | MCM21L15AC45 ² | 45 | 16 | |
| 1024×1 | MCM21L15AC70 ² | 70 | 16 | |
| 1024×1 | MCM2125AC45 | 45 | 16 | |
| 1024×1 | MCM2125AC55 | 55 | 16 | |
| 1024×1 | MCM2125AC70 | 70 | 16 | |
| 1024×1 | MCM21L25AC45 | 45 | 16 | |
| 1024 × 1 | MCM21L25AC70 | 70 | 16 | |
| 4096 × 1 | MCM6641P20 | 200 | 18 | |
| 4096 × 1 | MCM6641P25 | 250 | 18 | |
| 4096 × 1 | MCM6641P30 | 300 | 18 | |
| 4096 × 1 | MCM6641P45 | 450 | 18 | |
| 4096×1 | MCM66L41P20 | 200 | 18 | |
| 4096 × 1 | MCM66L41P25 | 250 | 18 | |
| 4096 × 1 | MCM66L41P30 | 300 | 18 | |
| 4096 × 1 | MCM66L41P45 | 450 | 18 | |
| 4096 × 1 | MCM2147C55 | 55 | 18 | |
| 4096×1 | MCM2147C70 | 70 | 18 | |
| 4096 × 1 | MCM2147C85 | 85 | 18 | |

CMOS STATIC RAMs (+5 Volts)

| Organization | Part Number | Access Time (ns max) | No. of Pins |
|--------------|---------------|-------------------------|----------------|
| 256 × 4 | MCM5101P65 | 650 | 22 |
| 256 × 4 | MCM5101P80 | 800 | 22 |
| 256 × 4 | MCM51L01P45 | 450 | 22 |
| 256 × 4 | MCM51L01P65 | 650 | 22 |
| 4096 × 1 | MCM65147P55* | 55 | 18 |
| 4096 × 1 | MCM65147P70 * | 70 | 18 |
| 4096 × 1 | MCM65147P85* | 85 | 18 |



ROMs

MOS STATIC ROMs (+5 Volts)

Character Generators³

| Organization | Part Number | Access Time (ns max) | No. of Pins |
|---------------------------|-------------|-------------------------|----------------|
| 128 × (7×5) | MCM6670P | 350 | 18 |
| $128 \times (7 \times 5)$ | MCM6674P | 350 | 18 |
| 128 × (9×7) | MCM66700P | 350 | 24 |
| $128 \times (9 \times 7)$ | MCM66710P | 350 | 24 |
| $128 \times (9 \times 7)$ | MCM66714P | 350 | 24 |
| $128 \times (9 \times 7)$ | MCM66720P | 350 | 24 |
| $128 \times (9 \times 7)$ | MCM66730P | 350 | 24 |
| $128 \times (9 \times 7)$ | MCM66734P | 350 | 24 |
| $128 \times (9 \times 7)$ | MCM66740P | 350 | 24 |
| $128 \times (9 \times 7)$ | MCM66750P | 350 | 24 |
| $128 \times (9 \times 7)$ | MCM66760P | 350 | 24 |
| $128 \times (9 \times 7)$ | MCM66770P | 350 | 24 |
| $128 \times (9 \times 7)$ | MCM66780P | 350 | 24 |
| $128 \times (9 \times 7)$ | MCM66790P | 350 | 24 |

BINARY ROMs (+5 Volts)

| Organization | Part Number | Access Time (ns max) | No. of Pins |
|-----------------|----------------|-------------------------|----------------|
| 1024 × 8 | MCM68A308P | 350 | 24 |
| 1024×8 | MCM68A308P74 | 350 | 24 |
| 1024 × 8 | MCM68B308P | 250 | 24 |
| 2048 × 8 | MCM68A316EP | 350 | 24 |
| 2048 × 8 | MCM68A316EP91⁴ | 350 | 24 |
| 4096 × 8 | MCM68A332P | 350 | 24 |
| 4096 × 8 | MCM68A332P24 | 350 | 24 |
| 8192 × 8 | MCM68A364P | 350 | 24 |
| 8192 × 8 | MCM68A364P3⁴ | 350 | 24 |
| 8192×8 | MCM68B364P | 250 | 24 |
| 8192 × 8 | MCM68365P25 | 250 | 24 |
| 8192 × 8 | MCM68365P35 | 350 | 24 |
| 8192 × 8 | MCM68366P25 | 250 | 24 |
| 8192×8 | MCM68366P35 | 350 | 24 |

CMOS ROMs (+5 Volts)

| Organization | Part Number | Access Time (ns max) | No. of Pins |
|----------------------------------|---|-------------------------|----------------|
| 256 × 4 | MCM14524 | 1200 | 16 |
| 2048 × 8 2048 × 8 2048 × 8 | MCM65516P43 MCM65516P43M⁴ MCM65516P55 | 430 430 550 | 18 18 18 |

EPROMS MOS EPROMS

| Organization | Part Number | Access Time (ns max) | Power Pins | No. of Pins |
|--------------|-------------|-------------------------|---------------|----------------|
| 1024 × 8 | MCM2708C | 450 | +12, ±5 V | 24 |
| 1024 × 8 | MCM27A08C | 300 | +12, ±5 V | 24 |
| 2048 × 8 | TMS2716C | 450 | + 12, ±5 V | 24 |
| 2048 × 8 | TMS27A16C | 300 | + 12, ±5 V | 24 |
| 2048 × 8 | MCM2716C | 450 | +5 V | 24 |
| 2048 × 8 | MCM2716C35 | 350 | +5 V | 24 |
| 4096 × 8 | MCM2532C | 450 | +5 V | 24 |
| 8192 × 8 | MCM68764L | 450 | +5 V | 24 |
| 8192 × 8 | MCM68766L | 450 | +5 V | 24 |
| 8192 × 8 | MCM68766L35 | 350 | +5 V | 24 |

EEPROMMOS EEPROM

| Organization | Part Number | Access Time (ns max) | Power Supplies | No. of Pins |
|--------------|-------------|----------------------|-------------------|----------------|
| 16 × 16 | MCM2801P | 10 μs | +5 V | 14 |
| 32 × 32 | MCM2802P* | 15 μ s | +5 V | 14 |
| 2048 × 8 | MCM2816C* | 450 ns | +5 V | 24 |

EPROM/ROM COMPARISON MOTOROLA'S PIN-COMPATIBLE EPROM FAMILY 64K 32K 16K A7 1 0 24 VCC 24 UCC 24 VCC A6 12 23 A8 23 A A 8 23 A8 22 A9 22 A9 22 A9 □3 A5 □3 21 DA12 ᅥ 21 VPP 21 VPP A4 🗆 d₅ 20 E/Progr 20 🗖 🛱 20 EVPP A3 □5 A2 🗆 6 19 A10 de 19 A10 19 A10 d 18 A11 18 A11 18 DE/Progr A1 □7 ds AO C 17 DQ7 17 DQ7 17 DO7 3 **₽**000 □ 9 16 DQ6 16DDQ6 16 DQ6 DQ1 10 15 DQ5 **d**10 15DQ5 15 7005 14 DQ4 **d**11 14 DQ4 **d**11 14 DQ4 DQ2 11 13DQ3 **d**12 13DQ3 Vss □12 12 13 DQ3 MCM2532 MCM2716 MCM68764 MOTOROLA'S PIN-COMPATIBLE ROM FAMILY 16K 64K A7 1 0 24 VCC **₫1**● 24 DVCC 24 VCC A6 □2 23 A8 23 A8 23 A8 □3 □4 □5 22 A9 A5 🖂 3 22 A9 22 A9 **□**3 **d**4 21 S 21 S A4 🗆 4 21 A12 20 DE 20 | S ₫5 20 5 A3 ☐ 5 녀 19 A10 뎌 19 A10 A2 06 19 A10 4 A1 07 18 A11 d7 18 A11 18 S ႕8 A0 d8 17 07 녀8 17 Q7 17 07 ㅁ ᆸ ᅃᆸ 16 Q6 16 🗆 🔾 6 16 06 Q1 🗖 10 15 05 **□**10 15DQ5 **₫10** 15 05 ᆸᇷ d11 02 11 14 04 14004 14 Q4 **d12 d**12 VSS □12 13**1**23 13 03 13 Q3 MCM68A364 MCM68A332 MCM68A316E **INDUSTRY STANDARD PINOUTS**

NOTES

Not all package options are listed.

Operating temperature range: 0°C to 70°C

FOOTNOTES

- ¹Motorola's innovative pin #1 refresh.
- ²All MOS memory outputs are three-state except the open collector MCM2115A series.
- 3Character generators include shifted and unshifted characters, ASCII alphanumeric control, math, Japanese, British, German, European and French symbols.
- 4Standard Patterns for MOS ROMs:

MCM68A308P7-MC6800 MIKbug/MINIbug

MCM68A316EP91 — Universal Code Converter and Character Generator

MCM68A332P2-SINE/COSINE Look-up Table

MCM68A364P3-LOG/ANTILOG Look-up Table

MCM65516P43M - MC146805 Monitor Program

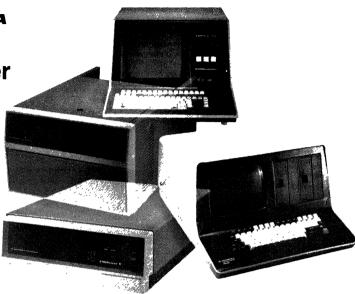
^{*}To be introduced

Development Systems and Board-Level Products



MOTOROLA

Microcomputer Development Systems



The key to developing a dedicated microcomputer system, and ultimately to manufacture and service the system, is a spectrum of support hardware and software ranging from evaluation and development aids to manufacturing and service instruments.

Motorola supports its various microprocessor and microcomputer lines with an array of hardware and software development systems that meet a wide range of customer needs.

EXORmacs

The EXORmacs Development System supports both 16-bit and future 32-bit microprocessor designs by taking advantage of the power and technological advancements of the 16-bit MC68000 MPU. EXORmacs' capability ranges from singleuser to multiuser hardware and software development.

EXORciser

The **EXORciser** is a modularized, expandable system for M6800 and M6809 emulation. It transcends process technologies to emulate or simulate a complete line of Motorola microcomputer components through dedicated plug-in accessories.

EXORterm

The **EXORterm Development System** adds video display and keyboard entry capability to the basic EXORciser, making it particularly suited to program development. Both EXORciser and EXORterm are never out-of-date. They can

be expanded with new plug-in and add-ons as quickly as new or improved component families are introduced. They offer limitless flexibility at a modest cost.

EXORset

The **EXORset** is an innovative and compact development system based on the high-performance MC6809 processor which fills the gap between very low-cost microprocessor evaluation kits and the high-end development systems such as the EXORciser.

ACCESSORIES

Complementing the development systems is a selection of compatible peripherals — a series of dot-matrix printers, a keyboard entry/display terminal, a dual floppy disk, and a hard disk storage system. Each is equipped with the appropriate interface circuitry that adapts it to Motorola development systems.

And Motorola facilitates the involved task of program development with a comprehensive software library of editors, assemblers, interpreters, and compilers that provide the man/machine interface in a variety of languages. Assembly language, of course. But also available are "compilers" that permit high-level language entry with MPL, FORTRAN, BASIC, COBOL and PASCAL.

At Motorola, product support development is a continuing large-scale effort that keeps pace with the development of the product itself.

BASIC-M, EXORciser*, EXORbug, EXORdisk, EXORmacs, EXORset, EXORterm, FIVEbug, MACSbug, VERSAbus, and VERSAbos are trademarks of Motorola Inc



EXORmacs

The EXORmacs is a state-of-the-art development system for designing and developing advanced 16-bit microprocessor based systems using Motorola families of microprocessors, microcomputers, and peripheral parts. It is also ideally suited for developing applications using the VERSAmodule family of 16-bit board level application products and accessories.

Designed for flexibility and ease of use, EXORmacs takes advantage of the power and features of the MC68000 microprocessor unit (MPU). EXORmacs reduces cost and development time by incorporating features which support 16-bit and future 32-bit microprocessor designs, as well as providing high-level language support through PASCAL. With additional terminals and multichannel communications modules, up to eight users may simultaneously develop M68000 programs. Each multichannel communications module requires one backplane slot and supports up to four users.

As a family of building blocks, EXORmacs capability ranges from the minimum requirements of a singleuser design up to a high performance multiuser hardware and software development system.

EXORmacs System Software

The M68000 software development package provides the user with a cost-effective and efficient Real-Time Operating System, structured Macro Assembler, Linkage Editor, CRT Text Editor, Symbolic Debugger and PASCAL Compiler.

RESIDENT MODULES M68000 MPU Module

Contains the MC68000 MPU chip, its clock system, a foursegment Memory Management Unit (MMU), primary and secondary map switching logic and firmware that provides module diagnostics. The MMU allows the system to allocate memory under control of the VERSAdos Operating System, and provides multitasking operation. This real-time multitasking operation system helps speed program development by allowing concurrent task execution.

DEbug Module

Houses MACSbug Firmware, bus arbitration logic, a parallel printer port, the RS-232C terminal port, and a downline load RS-232C host port.

Universal Disk Controller (Hard Disk Systems)

Features an MC68120 microprocessor emulator used to handle data requests from the M68000 system, and to provide self-contained module diagnostics for the disk. The use of this multiprocessing technique offers increased system performance which results in more efficient utilization of the processor's time. A floppy disk controller module is provided for floppy disk based systems.



256K Byte Dynamic Memory

Two 128K byte Dynamic Memory Modules provide EXORmacs with 128K 16-bit words of RAM which include byte parity. Parity is read during memory access, providing the MC68000 MPU with soft error status such that a memory re-try may be initiated. The base address may be set by the user through switch inputs. The chassis can support up to eight RAM modules providing the user with a megabyte of directly addressable resident memory.

EXORmacs System Peripherals

The complete EXORmacs system is configured with an intelligent terminal and either a hard disk or a floppy disk. Hard disk storage capacity is available up to 192 megabytes; for floppy disk, up to 2 megabytes.

EXORmacs System Printer (Optional)

Hard copy for the EXORmacs Development System is provided by a Model 703 matrix printer.

Expansion Modules

Multichannel Communications Module

This serial communications module provides multiuser terminal operation for the hard disk based EXORmacs. This module provides an interface to four asynchronous RS-232C serial devices and one parallel mode line printer. This multichannel module includes its own intelligent controller to interface directly with the VERSAbus. Each channel has its own baud rate select.

Remote Development Station

The Remote Development Station consists of a VERSAbus compatible 4-board slot chassis, power supply, station control module, USE module, and M68000 buffer pod and cable assembly. Built-in MACSbug firmware allows standalone debug capability plus host computer communications.

Bus State Analyzer for VERSAbus

The Real-Time Bus State Analyzer is a highly intelligent system diagnostic tool that is designed specifically for use with microprocessors. The Analyzer monitors 79 channels in real time and records events in a high speed 128 state trace memory. Supplied with the analyzer is a VERSAbus personality board.



VERSAbus Adapter Module

The VERSAbus Adapter Module (VAM) is an interface between an 8-bit EXORbus Module and the 16-bit VERSAbus. The EXORbus module mechanically inserts into the VAM, enabling VERSAbus to use various I/O modules, memory and Micromodules designed for the EXORbus. By using two VAMs at one address, a 16-bit communication ability is possible.

User System Emulator Module

Working with EXORmacs, the VERSAbus User System Emulator (USE) provides a complete software and hardware systems development station. It not only extends the debug power of the EXORmacs system into the user target system, but allows the user to specify whether the development system or his own system should respond to a given address. User System Emulator allows evaluation of prototype system hardware and software in the earliest stages of development, even before prototype memory and input/output facilities are built.

VERSAbus Dynamic Memory Modules

VERSAbus Dynamic Memory Modules offer a wide choice of RAM storage elements. These memory modules are supplied with byte parity, providing auto re-try on soft errors in the EXORmacs Development System.

128K Byte Dynamic RAM with parity 64K Byte Dynamic RAM with parity 32K Byte Dynamic RAM with parity

Auxiliary Modules

The VERSAbus Extender Module provides a convenient means for the routine testing or troubleshooting of EXOR-macs modules. The module under test is mechanically inserted into the Extender Module card guides, thus raising it to a convenient level for servicing. The Extender Module "extender" VERSAbus signals and power to the module under test.

The VERSAbus *Wirewrap Module* permits the user to construct and incorporate his custom circuits into an EXORmacs system. Features include standard pin spacing for 14, 16, 18, 22, 40 and 64 pin wirewrap sockets; positions for four axial-lead type bulk filter capacitors; and provision for decoupling capacitors.

EXORciser . . . for prototype development

The EXORciser is an expandable development system that allows emulation of any Motorola 8-bit microprocessor or microcomputer configuration, from the simplest to the most elaborate. It comes with an MPU Module that provides system timing and a DEbug Module that contains system firmware.

Both MC6800 or MC6809 MPU versions are offered in the EXORciser Development System.

With optional accessories, the EXORciser design and diagnostic functions can be extended to other members of the M6800 family, as well as other Motorola families including the NMOS MC68000, and CMOS MC146805 microcomputers.

The EXORciser with a USE option can be used to test and evaluate equipment external to its chassis. By removing the microprocessing unit from the user's system and connecting the USE cable from the EXORciser into the MPU's socket, the EXORciser with its EXbug firmware can be used to debug and troubleshoot microprocessor systems.

The EXORciser consists of a rugged cabinet with a builtin power supply, and a prewired bus-oriented 14-slot Motherboard with MPU and DEbug Modules. Together these elements form a development microcomputer, with the capability of adapting the unit to a specific design problem by adding optional I/O and memory modules. Adequate Motorola memory modules for the EXORciser can be selected to suit varying system configurations, especially to meet the increased memory requirement for high-level languages. The concept of add-on modules permits the user to purchase as few or as many as needed for the anticipated end functions of the systems to be developed. Using one slot each for a floppy disk and printer function, ten slots remain for memory and I/O expansion. The EXORciser is a system that is never outof-date, being at all times upgradable when new and expanded microcomputer functions become available.

EXORterm . . . for program development

The EXORterm 220 Development System adds video display and keyboard entry facilities to the capabilities of the basic EXORciser, making it particularly useful for software development. It consists of an integral card cage containing the EXORciser MPU and DEbug Modules, with provisions for six more standard EXORciser modules for system design flexibility.

EXORterm 220 contains a high-quality CRT with a full 1920-character screen and easily readable 7 \times 9 ASCII characters. A 59-key detachable keyboard incorporates 12 special keys encoded to invoke functions unique to a user's system. Its serial communications link has speeds to 9600 baud for information exchange.

The EXORciser/EXORterm card cage is compatible with the same wide selection of accessory boards. When the system is used in conjunction with a floppy disk system and printer, two of the six available Motherboard slots will be devoted to interface modules for these peripherals, leaving four slots for the expansion of memory, I/O, and/or accessory functions.



EXORsetComplete, Compact, Cost-effective

This very reasonably-priced, self-contained, desk top system provides a productive means of efficient and fast software development. EXORset fills the gap between low-cost evaluation kits and high-end development systems. EXORset offers these unique features in one system:

- MC6809 high-performance processor The expanded instruction set, addressing modes and architecture of the MC6809 allows sophisticated programming techniques such as structured programming, position independent codes, re-entrant routines and real-time operation.
- Full ASCII keyboard with 16 user-assigned function keys
- Dual mini-floppy disk drives and controller board Together these drives provide 328K bytes of mass storage.
- 9" CRT display
 - 22 lines of 80 characters
 - 16 lines of 40 characters
 - Full graphics

EXORciser/EXORterm Expansion Options... for additional processors

MC6801 DEVELOPMENT SYSTEM

The MC6801 Development System upgrades Motorola M6800 or M6809 EXORcisers for development of MC6801-based systems. All three modes of MC6801 operation — single-chip, expanded multiplexed and expanded non-multiplexed — are supported by this system.

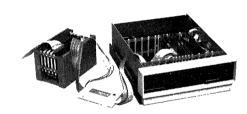
This support system fosters realtime emulation of the MC6801 application hardware and facilitates the debugging of software developed for use on the hardware.

MC6805 FAMILY DEVELOPMENT SYSTEM

The MC6805P2 Development System adapts M6800 or M6809-based EXORcisers to the development of systems based on the MC6805P2 and MC6805R2 microcomputers. Included in the support system are the printed circuit board module, extended cables for USE for both HMOS MC6805 versions, and an MDOS diskette containing the M6805 Cross Macro Assembler and FIVEbug (the system debug/monitor program). An optional adapter is available for MC6805R2/U2 system.



- 48K RAM and 12 sockets for 24K of EPROM/ROM
- · Complete software development package
 - EXORbug system monitor firmware
 - XDOS operating system
- MC6800, 01, 05, 09 Macro Assembler
- CRT Oriented Text Editor
- Diagnostics
- BASIC-M Interactive Compiler
- · Standard parallel printer interface



MC146805 DEVELOPMENT SYSTEM

The purpose of this 8-bit CMOS system is to provide an M6800 or M6809-based EXORciser with the capability to debug MC146805 applications in the actual hardware and software configuration of the user's final system.

It is possible to emulate all MC146805 inputs and to examine all the corresponding outputs via software control, or control the inputs and outputs via external user hardware. Thus, this development system offers an economical and expedient means for developing new applications prior to committing the programs to the final production masks.

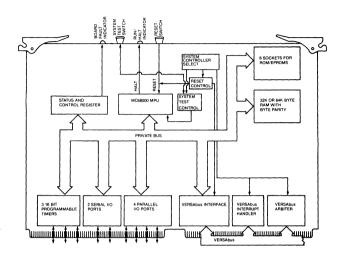
MC141000/1200 DEVELOPMENT SYSTEM

This 4-bit CMOS system is functionally similar to the 8-bit CMOS system, except that it is designed for simulating the MC141000/1200 microcomputer on an M6800-based EXORciser. It also requires 24K bytes of RAM and an EXORdisk.



VERSAmodules

VERSAmodules represent a new class of modular subsystems with which to implement a complete microcomputer system. Based on the 16-bit MC68000 microprocessor, the line was introduced in late 1980 and is scheduled for rapid expansion. Its powerful MC68000 microprocessor positions VERSAmodule microcomputer systems in the performance category of low-to-medium performance range minicomputers.



Monoboard Microcomputer

M68KVM01A Features

- 1. MC68000 MPU with 8 MHz clock
- 2. VERSAbus interface
- 2 serial I/O ports (RS-232C), one programmable synchronous/asynchronous and strappable for RS-422; second port async only; both terminal/modern selectable
- 4 parallel I/O ports (each with 8 data and 2 handshake lines)
- 5. Triple 16-bit programmable timer/counter
- 6. Backplane input/output connector
- 8 sockets for up to 64K bytes of pin compatible 2-, 4-, or 8K-byte ROM or EPROM
- 8. 32- or 64K-bytes DRAM with byte parity
- System test and reset switches and board status indicators (LEDs)
- System controller functions VERSAbus arbiter

VERSAbus system clock, reset, test, etc.

System Configuration

As part of the VERSAmodule introductory offering are a number of support accessories that permit immediate implementation of complete systems. The available support modules include Dynamic RAM modules with 32K, 64K, and 128K byte capacity, a Floppy Disk Controller module, a Multichannel Communications module, a Universal Intelligent Peripheral Controller module and a Universal Disk Controller System. A number of additional modules are planned for 1981/82 introduction.

All VERSAmodules are compatibly designed to operate with Motorola's versatile VERSAbus interconnect system which is designed for Multiprocessor operation, Direct Memory Access operations, Multi-Level Interrupt capability and Self-Test-control.

Together with a packaging system including power supplies, card cages, and chassis, presently available VER-SAmodules permit the configuration of microcomputers suitable for large-scale control and communications applications.

EXORbus, VERSAbus, and VERSAmodule are trademarks of Motorola Inc



SUPPORT MODULES

Dynamic Memory Modules

- 128K, 64K and 32K bytes versions available now
- . Includes byte parity with automatic re-try on parity error
- High density versions (256K/512K bytes) to be available

Floppy Disk Controller Module

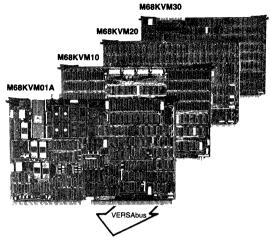
- · Controls up to four double-sided floppy disk drives
- Based on Intelligent Peripheral Controller

Multichannel Communications Module

- · Four asynchronous serial ports, RS-232C
- · Standard parallel printer port
- Based on Intelligent Peripheral Controller

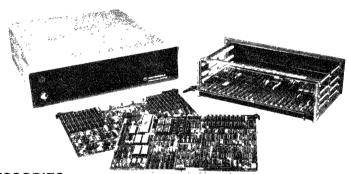
Universal Intelligent Peripheral Controller Module

- · Contains processor, ROM, RAM
- · Performs self-test during power-up
- · Test and diagnostic serial port
- · High speed DMA to VERSAbus



Universal Disk Controller System

- Two-board system provides industry standard interface to floppy and hard-disk drives
- Controls one or two 16M byte (expandable to 80M byte) fixed drives and 16M byte removable cartridge drives
- · Controls up to four double-sided floppy disk drives



PACKAGING AND ACCESSORIES

51/4" Chassis with Power Supply

- · 4-slot card cage, expandable to 12 slots in groups of 4
- Power supply (15 A or 30 A options)
- · Forced air cooling
- 19" rack mountable with slides provided
- 24" depth

4-Slot Card Cage (stand-alone)

· Expandable to 12 slots in groups of 4

Power supplies

- Power fail detect
- Low power option (15 A @ 5 Vdc, ± 12 Vdc)
- High power option (30 A @ 5 Vdc, ± 12 Vdc, + 15 Vdc)

VERSAbus Adapter Module

 Provides VERSAbus systems with the ability to utilize EX-ORbus family modules including Micromodules

VERSAbus Extender Module

- Mechanical inserters and ejectors for module under test to extender module
- · Full length card guides

VERSAbus Wirewrap Module

 Standard pin spacing for 14, 16, 18, 24, 40 and 64 pin wirewrap sockets



MOTOROLA

MICROPROCESSOR MODULES

MONOBOARD MICROCOMPUTERS

Choose from a selection of differently configured singleboard microcomputers; add a suitable power supply and, perhaps, some additional external memory; put these into an appropriately available enclosure (or design your own); and you have a complete microcomputer - ready to receive your dedicated firmware and go to work.

Motorola's Micromodule monoboard microcomputers offer a choice of variations to best match a particular end-use.

Typical Monoboard Microcomputer RS 2320 RS 422 Baud Rate RAM 2K 8 EXORbus BUFFERS M68MM19, 19A

| | Parallel | | Serial I/O | | Memo | ory | | Clock | |
|-------------|-------------------------|----------------------|------------|--------------|--------|-----|------|---------------------|----------------------------|
| Part No. | Input/Output | RS-232C | RS-422 | 20mA | ROM | RAM | MPU | (MHz) | Options |
| M68MM01 | 3 PIAs/60 Lines | | | | To 4K | 1K | 6800 | 1 | |
| M68MM01A2 | 2 PIAs/40 Lines | 1 ACIA | | Use MM11° | To 8K | 1K | 6800 | 1 | |
| M68MM01B | 1 PIA/20 Lines 1 PTM | | | | To 4K | 128 | 6802 | 1 | Not Expandable |
| M68MM01B1A | 1 PIA/20 Lines 1 PTM | 1 ACIA | | Use MM11* | To 4K | 384 | 6802 | 1 | Cassette I/O |
| M68MM01D | Printer Port 1 PTM | 1 ACIA | (OPT) | Use MM11* | To 10K | | 6800 | 1, 1 5 | Use 2K RAMS in ROM Sockets |
| M68MM17 | 1 PIA/20 Lines 1 PTM | 2 ACIA | | Use MM11* | To 48K | | 6809 | 1 | Use RAMs in ROM Sockets |
| M68MM19/19A | 1 PIA/20 Lines 1 PTM | 1 ACIA or SSDA | (OPT) | Use MM11* | To 16K | 2K | 6809 | 1(MM19) 2(MM19A) | Replace ACIA with SSDA † |

NOTES

PTM

16 Programmable I/O Data Lines and 4 Control Lines

Three 16-bit Programmable Counter/Timers

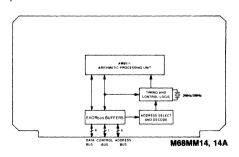
ACIA Asynchronous Communications Synchronous Communications

Option-requires additional Micromodule (MM11)

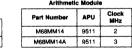
(RS-232C to 20 mA Current Loop Adapter)
Option-requires slight board modification

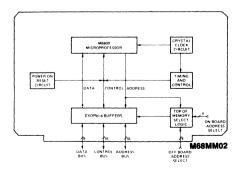
PROCESSOR SUBASSEMBLIES

For greater design flexibility than a single monoboard computer can provide, a selection of processor subassemblies gives your system the characteristics it needs, at an affordable cost. These subassemblies, in conjunction with the auxiliary boards on the following pages, allow almost limitless diversification or expansion of microcomputer functional capabilities.



| Processor Module | | | | | | |
|------------------|------|--------------|--|--|--|--|
| Part Number | MPU | Clock MHz | | | | |
| M68MM02 | 6800 | 1 | | | | |





MOTOROLA

INPUT/OUTPUT MODULES

If your system requires additional input or output capabilities, the Micromodule product line provides an extensive offering of both digital and analog, input and output modules.

These input/output modules are all compatible with the various microprocessor modules.

Digital — Parallel

| | Part Number/Name | | Level | Relav | Opto Isolated | |
|-----------------|---|---------------|--------|--------|---------------------------|--------|
| | | | Output | Output | Input | Output |
| M68MM03 | 32/32 Input/Output Module | 32 | 32 | | | |
| MEX6820, 6821-2 | (2MHz) Input/Output Module | 2 PIAs/40 I/O | | | | |
| M68MM13A | Digital Output Module | | | 16 | | |
| M68MM13B | Digital Output Module | | | 32 | | |
| M68MM13C | Optically Isolated Digital Input Module | | | | 24 (voltage in) | |
| M68MM13D | Optically Isolated Digital Input Module | | | | 24 (switch closures) | |
| M68MM23 | Optically Isolated Input/Output Module | | | | 1 to 16 AC or DC I/O Mode | |

Digital - Serial

| Dark No. | Part Number/Name | | Interface | | | | | |
|------------------|--|---|--------------|------------------|-------|-------------------------------|--|--|
| Part Number/Name | | RS-232C | RS-422 | RS-423 | 20 mA | Bus | | |
| M68MM07 | Quad Communications Module | 4* | 4* | 4* | 4* | | | |
| MEX6850 | ACIA Module | 1 | | | 1 | | | |
| MEX6850-2 | 1MHz ACIA/SSDA Module | ** | ** | ** | ** | | | |
| M68MM11 | RS-232C to TTY Adapter | | RS-232C to 2 | 20 mA Translator | | | | |
| M68MM12/12-1*** | GPIB Listener/Talker/ Controller Module | | | | | Listener/Talker Controller | | |
| M68MM12A/12A1*** | GPIB Listener/Talker Module | | | | | Listener/Talker | | |
| M68DIM2A | Display Interface | Composite Video at 0 5V, 75 Ω (Compatible with M68MDM1 CRT) | | | | | | |

^{*}ACIA or SSDA and Interface are User Options **SSDA and Interface must be installed by the user ***MM12, 12A for 6800-based systems MM12-1, 12A1 for 6809-based systems.

Analog

| D | Number/Name | A | D/A | | | |
|------------|---------------------------|--|---|-------------|-------------|--|
| Part | Number/Name | High Level 12-Bit | Low Level 16-Bit | Voltage | Current | |
| M68MM05A | High-Level, 12-Bit | 8 Channel Differential | | | | |
| M68MM05B | High-Level, 12-Bit | 16 Channel Single Ended | | | | |
| M68MM15A | High-Level, 12-Bit | 8 Channel Differential 16 Channel Single Ended | | | | |
| M68MM15A1 | High-Level, 12-Bit | 16 Channel Differential 32 Channel Single Ended | | | | |
| M68MM15B | Low-Level, 16-Bit | | 1 Channel Isolated Expandable to 16 channels | | | |
| M68MM15BEX | Low-Level Expander Module | | 1-4 Channel Expander | | | |
| M68MM05C | Quad 12-Bit D/A Module | | | 4 Channel | | |
| M68MM15CV | Voltage D/A Module | | | 1-4 Channel | | |
| M68MM15CI | Current D/A Module | | | | 1-4 Channel | |



MEMORY MODULES

System memory requirements for EPROM/ROM or RAM can be expanded through the inclusion of the various memory modules offered in the micromodule product line. Addi-

tional memory can be added to a system as the design requires.

| | | | RAM | | | |
|-------------|---|-----------|-------------|-------------------|--|--|
| | Part Number/Name | EPROM/ROM | Static | Hidden Refrest | | |
| M68MM04 | 16K EPROM/ROM Module | 1 to 16K | | | | |
| M68MM04A | ROM/EPROM Module | 1 to 64K | (2 to 32K)* | | | |
| M68MM06 | 2K Static RAM Module | | 2K | | | |
| M68MM09 | 4K Static CMOS RAM Module | | 4K** | | | |
| MEX6816-1HR | 16K Dynamic RAM Module w/Hidden Refresh | | | 16K † | | |
| MEX68RR | EPROM/RAM Module | 1 to 16K | 512 | | | |

^{*}Using Pin Compatible RAMs **With On-Board Battery Backup †32K, 48K and 64K versions available

FIRMWARE/SOFTWARE

The Micromodule product line includes an offering of Monitor/DEbug ROMs, a high-level language BASIC Interpreter, a Real-Time FORTRAN Compiler and a Real-Time Executive

to assist you in operating software development and debugging.

| Par | t Number/Name | Functional Description | | | | |
|----------------------------|--|---|--|--|--|--|
| M68MM08A | MICRObug (6800) Monitor/DEbug ROM for use with M68MM01A2 | | | | | |
| M68BASRC2 | BASIC (6800) | BASIC in EPROMs for use with MICRObug | | | | |
| M68BASRM2 | | BASIC EPROMs on a module | | | | |
| M68RTFR02M | Real-Time FORTRAN (6800) | Real-Time FORTRAN compiler with drivers for I/O Micromodules on MDOS Diskette | | | | |
| M6809BASICM | BASIC-M (6809) | Interactive BASIC-M Compiler | | | | |
| M6809RMS09 | Real-Time Executive (6809) | Multitask Real-Time Executive that is relocatable and ROMable. | | | | |
| M68MM12SWM M68MM12-1SWM | Micromodule 12 Software (6800) (6809) | Source code on MDOS diskette of on-board EPROM which provides implementation of GPIB protocol. Also includes a how-to-use training program | | | | |
| M68MM12ASWM | Micromodule 12A Software (6800) | Source code on MDOS diskette of software required to implement the GPIB Listener/Talker protocol | | | | |
| M68MM12A1SWM | (6809) | Also includes a how-to-use training program and a demonstration package | | | | |
| M68MM19SB | SUPERbug (6809) | MM19 System Monitor with Utility, I/O, and Linkage Routines | | | | |

MOTOROLA

PACKAGING/HARDWARE

System packaging offerings include open-frame card cages, rack-mount chassis with power supply and fan, and a triple output power supply. To support custom circuit prototyping, two versions of a wirewrap module are available.

Card Cages, Chassis and Power Supply

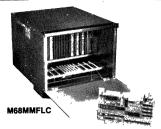
| | Part Number/Name | Dimensions (Inches) |
|-----------------------|----------------------------|---------------------|
| rd Cages Only | | |
| M68MMCC05 | 5-slot Open-Frame Cage | 11 3 x 7 04 x 6 9 |
| M68MMCC10 | 10-slot Open-Frame Cage | 11 3 x 11 04 x 6 9 |
| assis With Power Supp | ply | |
| M68MMSC | 5-slot Rack Mount Chassis | 10 34 x 19 x 6 97 |
| M68MMLC | 10-slot Rack Mount Chassis | 18 74 x 19 x 6 97 |
| M68MMFLC | 14-slot Rack Mount Chassis | 19 50 x 19 x 13.75 |
| ower Supply Only | | |
| M68MMPS1 | Power Supply +5V, ± 12V | 95 x 6 25 x 5 0 |

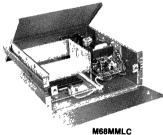
Auxiliary Support Modules

| | Part Number/Name | Dimension |
|------------|---|-------------|
| MEX68WW | Wirewrap Board | 9 75 x 6.00 |
| MEX68USM | Universal Support Module | 9 75 x 6.00 |
| MEX68XT | Extender Module | 9.75 x 9 00 |
| M68MM10A | Power Fail Detect | 9 75 x 6.00 |
| M68MM10B | Power Fail Detect with Battery Backed-up Clock | 9 75 x 6 00 |
| M68MM10C | Battery Backed-up Clock | 9 75 x 6.00 |
| M68MM16 | Combo ROM — RAM — I/O module 2 PIA, 1 PTM, 1 ACIA, 2K RAM, To 32K ROM/EPROM | 9.75 x 6.00 |
| RT Monitor | | |
| M68MDM1 | 5" CRT Display Monitor | T |

Mounting/Hardware

| | Part Number/Name | Functional Description | | |
|-------------|----------------------------------|---|--|--|
| M68MMLK | Slide Kit, Long Chassis | Rack Mounting slide kit for M68MMLC | | |
| M68MMSK | Slide Kit, Short Chassis | Rack Mounting slide kit for M68MMSC | | |
| M68MMFLK | Slide Kit, Front-Load Chassis | Rack Mounting slide kit for M68MMFLC | | |
| M68MM23IKIT | Installation Kit, Micromodule 23 | Installation kit for mounting two Optically Isolated I/O Modules in an M68MMFLC | | |
| M68MMI/OC | Parallel I/O Adapter Set | interfaces parallel port on MM19 or MM16 to standard optically isolated relay boards | | |











REFERENCE GUIDE: Selection by MPU/MCU Supported

PRODUCT CATEGORY: EXORmacs (68000 only)

| Type Number | Description |
|-------------|--|
| M68KMCCM | Multichannel Communications Module |
| MEX68KADP | 6800 Bus Adapter Board |
| M68KBSA | 68000 Bus State Analyzer |
| M68KEXTM | VERSAbus Extender Module |
| M68KFD1102 | EXORdisk III for EXORmacs |
| M68KMACSF1 | 68000 EXORmacs Floppy Disk Development System |
| M68KMACSH1 | 68000 EXORmacs Hard Disk Development System (32MB Hard Disk) |
| M68KMACSH1A | 68000 EXORmacs Hard Disk Development System (96MB Hard Disk) |
| M68KUSE | M68000 Single User Emulator (USE) |
| M68KVAM | VERSAbus Adapter Module |
| M68KWW | VERSAbus Wirewrap Module |
| M68K32DP | 32K Byte VERSAbus RAM Module |
| M68K64DP | 64K Byte VERSAbus RAM Module |
| M68K128DP | 128K Byte VERSAbus RAM Module |
| M68K703LP1 | EXORmacs Printer 703, 110 V |
| M68KRDS1 | EXORmacs Remote Development Station with USE |
| M68KRDS2 | EXORmacs Remote Development Station without USE |
| M68KMACSRK | EXORmacs Rack Mount Kit |

PRODUCT CATEGORY: EXORciser

| Type Number | 141000 | 00089 | 6801 | 6089 | 6805 | 6800/02 | Description |
|-------------|--------|-------|------|------|------|---------|---|
| MEX68IC | | | | Х | Х | Х | I/O Interconnect Cable (Use with MEX6820) |
| MEX68IC2 | 1 | l | l | X | X | х | i/O Interconnect Cable (Use with MEX6821-2) |
| MEX68KDM | 1 | X | } | | 1 | | MC68000 Design Module |
| MEX68RK2 | 1 | X | } | X | X | X | Rack Mounting Kit EXORciser I & II |
| MEX68RR | 1 | X | 1 | X | X | х | EPROM/RAM Module |
| MEX68SA | | 1 | 1 | 1 | i | х | System Analyzer |
| MEX68SA2 | | l | 1 | į . | 1 | x | System Analyzer II |
| MEX68USEC | 1 | l | 1 | 1 | | x | User System Evaluator |
| MEX68USM | 1 | | | X | 1 | х | Universal Support Module |
| MEX68WW | 1 | l | 1 | X | X | X | Wirewrap Module |
| MEX68XT | 1 | } | 1 | X | X | х | Extender Module |
| MEX6801EVM | 1 | 1 | X | 1 | } | | Evaluation Module |
| MEX6801EVM1 | 1 | i | X | | } | l | 68701 Programming Module |
| MEX6801 | 1 | l | X | | ł | 1 | Development System |
| MEX6802-46 | 1 | | ł | 1 | 1 | X | MC6802/46 Support Module |
| MEX6805 | 1 | | | 1 | X | 1 | Development System |
| MEX6805R2 | 1 | 1 | 1 | 1 | X | 1 | Adapter for MC6805R2/U2 |
| MEX6808-22 | 1 | X | X | X | X | X | 8K Static RAM Module with Parity |
| MEX6809KT | 1 | 1 | } | X | } | l | 6809 Upgrade for EXORciser or EXORterm |
| MEX6812-1 | 1 | X | X | X | X | X | 2K Static RAM Module |
| MEX6816-1HR | ł | X | X | X | X | X | 16K Dynamic RAM Module with Hidden Refresh |
| MEX6816-22D | 1 | X | X | X | X | X | 16K Dynamic RAM Module with Parity |
| MEX6816-22S | 1 | X | X | X | X | X | 16K Static RAM Module with Parity |
| MEX6820 | 1 | X | X | X | X | х | Input/Output Module |
| MEX6821-2 | | X | X | X | X | X | Input/Output II Module |
| MEX6832-1HR | | X | X | X | X | X | 32K Dynamic RAM Module with Hidden Refresh |
| MEX6832-22 | 1 | X | X | X | X | × | 32K Dynamic RAM Module with Parity |
| MEX6845 | 1 | x | X | × | X | X | MC6845 CRT Controller Module |
| MEX6848-1HR | 1 | X | X | × | X | X | 48K Dynamic RAM Module with Hidden Refresh |
| MEX6848-22 | 1 | X | X | X | X | X | 48K Dynamic RAM Module with Parity |
| MEX6850 | | X | X | × | X | X | ACIA Module |
| MEX6850-2 | | X | X | X | X | X | ACIA/SSDA Module |
| MEX6854 | | X | X | X | X | X | MC6854 ADLC Support Module |
| MEX6864-1HR | 1 | x | X | X | X | X | 64K Dynamic RAM Module with Hidden Refresh |

REFERENCE GUIDE: Selection by MPU/MCU Supported (continued)

PRODUCT CATEGORY: EXORcisers (continued)

| | | _ | _ | _ | - | | |
|--------------|--------|-------|------|------|------|---------|--|
| Type Number | 141000 | 00089 | 1089 | 6089 | 6805 | 6800/02 | Description |
| MEX6864-22 | | х | X | X | х | х | 64 Dynamic RAM Memory with Parity |
| MEX141000M | x | 1 | 1 | 1 | 1 | 1 | MC141000/1200 Development System |
| MEX146805 | ' | | l | 1 | x | | MC146805E2 Development System |
| MEX68488 | 1 | x | x | x | | x | MC68488 GPIA Support Module |
| M68BASR010M | 1 | | `` | `` | 1 | x | Resident BASIC Interpreter on 6800 MDOS Diskette |
| M68COBOL010M | 1 | 1 | 1 | 1 | 1 | x | Resident ANS COBOL Compiler on 6800 MDOS Diskette |
| M68FTNR012M | 1 | ļ | 1 |] | l | x | Resident FORTRAN Compiler and Linking Loader on 6800 MDOS Diskette |
| M68K0XASMBL0 | 1 | х | 1 | 1 | | 1 | 68000 Cross Macro Assembler on 6800 MDOS Diskette |
| M68K0XASMBL1 | 1 | x | 1 | l | 1 | | 68000 Cross Macro Assembler on 6809 MDOS Diskette |
| M68K0XPASCL1 | | ' | 1 | 1 | 1 | | Cross PASCAL Compiler on 6809 MDOS Diskette |
| M68MPLR020M | l | l | l | l | l | x | Resident MPL Compiler on 6800 MDOS Diskette |
| M68PANEL220 | 1 | x | x | x | x | X | 6809 Front Panel Conv. of EXORterm 200 |
| M68PP3 | | X | X | X | | x | PROM Programmer III |
| M68PP3-1 | | X | X | X | | х | Personality Module & Software for PPIII to allow Programming of MCM2532 and MCM68764 |
| M68RTFR02M | 1 | 1 | 1 | 1 | 1 | x | Resident Real-Time FORTRAN Compiler on MDOS Diskette for 6800 |
| M6800DOWNLD | 1 | 1 | X | 1 | 1 | x | 6800/6801 Down-Line-Load ROM |
| M6800EXOR | | ł | | 1 | 1 | x | M6800 EXORciser II Development |
| M6800EXORU | 1 | | 1 | ĺ | 1 | x | M6800 EXORciser II USE Development System 110 V |
| M6800SMDOS | 1 | l | | 1 | | X | 6800 CRT Editor/Macro Assembler with MDOS |
| M6800XASMBL1 | 1 | 1 | x | 1 | | x | 6800/6801 Cross Macro Assembler |
| M6805MASC01M | | 1 | 1 | ļ | x | (| 6805 Cross Macro Assembler and Linking Loader on MDOS Diskette |
| M6809BASICM | 1 | 1 | 1 | X | | 1 | Resident BASIC-M Interactive Compiler |
| M6809DOWNLD | 1 | 1 | 1 | X | 1 | (| 6809 Down-Line-Load ROM |
| M6809EXOR | 1 | 1 | | X | 1 | 1 | M6809 EXORciser II Development System 110 V |
| M6809FORTRN | l | 1 | | X | 1 | 1 | 6809 Resident FORTRAN Compiler |
| M6809MASC01M | | 1 | 1 | X | ł | 1 | 6809 Cross Macro Assembler and Linking Loader on MDOS Diskette |
| M6809MPL | 1 | 1 | | Х | l | 1 | 6809 Resident MPL Compiler on MDOS Diskette |
| M6809PASCLC | 1 | 1 | 1 | X | 1 | ١ | 6809 Resident PASCAL Compiler |
| M6809PASCLI | 1 | 1 | | X | 1 | 1 | Resident PASCAL Interpreter |
| M6809SA | 1 | 1 | 1 | X | 1 | 1 | System Analyzer II |
| M6809SMDOS | 1 | 1 | | X | 1 | Ì | 6809 CRT Editor/Macro Assembler with MDOS |
| M6809USE | | | 1 | X | | 1 | User System Evaluator |
| M6822 | 1 | 1 | 1 | 1 | 1 | x | Blank Cassette |
| M6833 | 1 | X | X | X | X | X | Blank Diskettes (SS/SD) |
| M6834 | 1 | x | X | X | x | x | Blank Diskette (DS/SD) |

PRODUCT CATEGORY: EXORterm

| Type Number | 6089 | 0089 | Description |
|------------------------|------|------|--|
| M6800TERM M6809TERM | х | X | M6800 EXORterm 220 Development System M6809 EXORterm 220 Development System |

PRODUCT CATEGORY: EXORset

| Type Number | 6089 | 9089 | 1089 | 6800/02 | Description |
|--------------|------|------|------|---------|--|
| M6809SET301A | Х | х | х | x | M6809 EXORset 30A Development System 110 V |
| M6835 | X | Х | Х | Х | Mini-Diskette (Package of 10) |
| M68SETRAMEX | X | Х | Х | X | EXORset RAM Expansion Kit |
| M6809SXDOS | Х | Х | X | Х | EXORset 30 to 30A Software Upgrade |

REFERENCE GUIDE: Selection by MPU/MCU Supported (continued)

PRODUCT CATEGORY: PERIPHERALS

| Type Number | 00089 | 6089 | 6805 | 6802 | 0089 | Description |
|--------------|-------|------|------|------|------|--|
| M68DSK2 | 1 | х | x | x | x | EXORdisk II 110 V |
| M68DSK3 | 1 | x | x | • | 1 | EXORdisk III 110 V |
| M68SFDRK3 | l | x | X | | x | Rack Mounting Kit, EXORdisk II and III |
| M68SFDU1102E | 1 | X | X | ł | X | EXORdisk IIIE Expansion Unit, 110 V |
| M68SP702C10 | 1 | × | x | x | x | Microsystems Printer 702, 110 V |
| MPRINT703 | X | x | x | x | x | Microsystems Printer 703, 110 V |
| M68SXD10155 | X | × | X | X | x | EXORterm 155 |
| M68SVS20155 | X | X | x | X | x | EXORterm 150 to 155 Conversion Kit |
| M68KHDS32-1 | X | ł | İ | | 1 | 32MB Hard Disk |
| M68KHDS96-1 | X | 1 | 1 | 1 | 1 | 96MB Hard Disk |
| M68KHDE32-1 | X | | l | | 1 | 32MB Hard Disk Expansion |
| M68KHDE96-1 | X | | 1 | | | 96MB Hard Disk Expansion |
| M68CART | X | ł | l | 1 | ł | Hard Disk Cartridge |

PRODUCT CATEGORY: CROSS SOFTWARE

| | | _ | | | |
|--------------|-------|-----|-----|------|---|
| | 68000 | 6 | - | | |
| Ì | 8 | 689 | 680 | 6800 | |
| Type Number | 9 | | 9 | 9 | Description |
| M68EML0211E | | | | X | Simulator/Sigma 9/Punch Card |
| M68EML0211F | ļ | İ | 1 | x | Simulator/Sigma 9/Magnetic Tape |
| M68EML0411E | | 1 | } | x | Simulator/HP2100/Punch Card |
| M68EML0411F | 1 | | 1 | x | Simulator/HP2100 Magnetic Tape |
| M68EML0711E | | } | } | X | Simulator/IBM360-370/Punch Card |
| M68EML0711F | | Ì | } | X | Simulator/IBM360-370/Magnetic Tape |
| M68EML0812E | | 1 | ĺ | x | Simulator/Nova/Punch Card |
| M68EML0812F | | l | 1 | x | Simulator/Nova/Magnetic Tape |
| M68EML0911E | [| 1 | 1 | x | Simulator/HIS6000/Punch Card |
| M68EML0911F | ł | 1 | 1 | x | Simulator/HIS6000/Magnetic Tape |
| M68EML1012F | 1 | 1 | 1 | x | Simulator/CDC6000/Magnetic Tape |
| M68EML1111E | ł | 1 | 1 | X | Simulator/PDP-11/Punch Card |
| M68EML1111F | 1 | 1 | 1 | x | Simulator/PDP-11/Magnetic Tape |
| M68K0SIMLTR2 | X | | 1 | 1 | Simulator/IBM370/Magnetic Tape |
| M68K0XASMBL2 | х | l | 1 | 1 | Cross Assembler/IBM370/Magnetic Tape |
| M68K0XASMBL3 | х | 1 | 1 | | Cross Assembler/PDP-11/Magnetic Tape |
| M68K0XPASCL2 | х | l | 1 | 1 | Cross PASCAL/IBM 370/Magnetic Tape |
| M68MPL0212E | ŀ | 1 | 1 | x | MPL Compiler/Sigma 9/Punch Card |
| M68MPL0212F | ľ | l | 1 | x | MPL Compiler/Sigma 9/Magnetic Tape |
| M68MPL0712E | ŀ | 1 | 1 | x | MPL Compiler/360-370/Punch Card |
| M68MPL0712F | ŀ | l | 1 | x | MPL Compiler/360-370/Magnetic Tape |
| M68MPL0912E | ļ | [| 1 | x | MPL Compiler/HIS6000/Punch Card |
| M68MPL0912F | | ł | 1 | x | MPL Compiler/HIS6000/Magnetic Tape |
| M68MPL1012E | ļ | | 1 | x | MPL Compiler/CDC6000/Punch Card |
| M68MPL1012F | ł | ł | l | X | MPL Compiler/CDC6000/Magnetic Tape |
| M68SAM0214E | | İ |] | x | Cross Assembler/Sigma 9/Punch Card |
| M68SAM0214F | ŀ | ł | } | x | Cross Assembler/Sigma 9/Magnetic Tape |
| M68SAM0413E | 1 | 1 | | x | Cross Assembler/HP2100/Punch Card |
| M68SAM0413F | | 1 | 1 | x | Cross Assembler/HP2100/Magnetic Tape |
| M68SAM0713E | 1 | | 1 | x | Cross Assembler/IBM 360-370/Punch Card |
| M68SAM0713F | | | 1 | x | Cross Assembler/IBM 360-370/Magnetic Tape |
| M68SAM0814E | | 1 | 1 | x | Cross Assembler/Nova/Punch Card |
| M68SAM0814F | | 1 | | x | Cross Assembler/Nova/Magnetic Tape |
| M68SAM0912E | | 1 | l | x | Cross Assembler/HIS6000/Punch Card |
| M68SAM0912F | | 1 | 1 | x | Cross Assembler/HIS6000/Magnetic Tape |
| M68SAM1014E | | 1 | | x | Cross Assembler/CDC6000/Punch Card |
| M68SAM1014F | 1 | | | x | Cross Assembler/CDC6000/Magnetic Tape |
| M68SAM1113F | | 1 | 1 | x | Cross Assembler/PDP-11/Magnetic Tape |
| M6809XASMBL2 | | X | | | Cross Assembler/IBM370/Magnetic Tape |
| M6809XASMBL3 | | × | | | Cross Assembler/PDP-11/Magnetic Tape |

REFERENCE GUIDE: Selection by MPU/MCU Supported (continued)

PRODUCT CATEGORY: TEST EQUIPMENT

| Type Number | 0089 | Description | - |
|-------------|------|----------------------------------|---|
| M68UCANA1 | Х | Microcomputer Analyzer 110 Volts | 1 |

PRODUCT CATEGORY: USERS GROUP (6800 only)

| Type Number | Description |
|-------------|----------------------|
| M6800UG | User's Group Library |

PRODUCT CATEGORY: VERSAmodules (68000 only)

| Type Number | Description |
|-------------|---|
| M68K0RMS68K | M68000 Real-Time Multitasking, Software (Object) on EXORmacs Diskette |
| M68KVM01A1 | 68000 16-Bit Monoboard Microcomputer, 32K RAM |
| M68KVM01A2 | 68000 16-Bit Monoboard Microcomputer, 64K RAM |
| M68KVMCC1 | 4-Slot Card Cage |
| M68KVMCH1-1 | VERSAmodule System Chassis, 15 Amps-5 Vdc, 110 V |
| M68KVM10-1 | 32K Byte Dynamic RAM Module |
| M68KVM10-2 | 64K Byte Dynamic RAM Module |
| M68KVM10-3 | 128K Byte Dynamic RAM Module |
| M68KVM20 | Floppy Disk Controller Module |
| M68KVM21 | Universal Disk Controller |
| M68KVM30 | 4-Channel Serial Communication Module |
| M68KVM60 | Universal Intelligent Peripheral Controller Module |
| M68KVBUG | VERSAbug Debug Monitor Firmware Package |

PRODUCT CATEGORY: MICROMODULES

| Type Number | 6809 | 6802 | 089 | Description | | |
|-------------|------|------|-----|---|--|--|
| MEC68MIN2 | | | х | MINIBUG 2 ROM | | |
| MEC68MIN3 | 1 | | x | MINIBUG 3 ROM | | |
| M68BASRC1 | | | x | Resident BASIC Interpreter ROM Set (MINIBUG II-Based) | | |
| M68BASRC2 | } | 1 | x | Resident BASIC Interpreter ROM Set (MICRObug-Based) | | |
| M68BASRM1 | İ | l | x | Resident BASIC Interpreter Module (MINIBUG II-Based) | | |
| M68BASRM2 | 1 | | x | Resident BASIC Interpreter Module (Micromodules) | | |
| M68DIM2A | x | х | x | Display Interface Module | | |
| M68EAB1 | | | x | Resident Editor/Assembler and BASIC Interpreter Module (MINIBUG II-Based) | | |
| M68EAB2 | 1 | | x | Resident Editor/Assembler and BASIC Interpreter Module (Micromodules) | | |
| M68EAM1 | l | | x | Resident Editor/Assembler Module (MINIBUG II and Micromodules) | | |
| M68KBD1 | X | X | x | ASCII Keyboard | | |
| M68MDM1 | X | x | x | 5" Display Monitor | | |
| M68MMCC05 | X | х | X | Card Cage, 5-Card | | |
| M68MMCC10 | X | X | x | Card Cage, 10-Card | | |
| M68MMFLC1 | X | X | X | Front Load Chassis, 14 Card, 110 V | | |
| M68MMFLK | X | х | x | Rack Mounting Slide Kit, FLC | | |
| M68MMLC1 | X | Х | X | Long Chassis, 10-Card, 110 V | | |
| M68MMLK | X | X | х | Rack Mounting Kit, Long Chassis | | |
| M68MMPS1-1 | X | X | X | Micromodule, EXORciser, EXORterm, DC Power Supply, 110 V | | |

REFERENCE GUIDE: Selection by MPU/MCU Supported (continued) PRODUCT CATEGORY: MICROMODULES (continued)

| | 6809 | 6802 | 6800 | |
|---------------------|------|------|------|--|
| Type Number | ۵ | ۵ | 8 | Description |
| M68MMSC1 | X | X | Х | Short Chassis, 5-Card, 110 V |
| M68MMSK | X | X | x | Rack Mounting Kit, Short Chassis |
| M68MM01 | 1 | | x | Monoboard Microcomputer |
| M68MM01A2 | l | 1 | x | Monoboard Microcomputer (with four 2K × 8 EPROM/ROM Sockets) |
| M68MM01B | l | X | | Monoboard Microcomputer |
| M68MM01B1A | | x | | Monoboard Microcomputer |
| M68MM01D | 1 | | x | Monoboard Microcomputer |
| M68MM02 | | 1 | x | CPU Module |
| M68MM03 | x | x | X | 32/32 Input/Output Module |
| M68MM03-1 | X | x | x | 32/32 Input/Output Module (with 4.7K Termination Option) |
| M68MM03-2 | X | X | x | 32/32 Input/Output Module (with 330/220 Termination Option) |
| M68MM04 | x | x | x | 16K EPROM/ROM Module |
| M68MM04A | x | x | x | 16 Socket EPROM, ROM or RAM Module |
| M68MM05A | x | x | x | |
| M68MM05B | x | x | x | 8-Channel, 12-Bit Differential Input A/D Module |
| | x | X | | 16-Channel, 12-Bit Single Ended Input A/D Module |
| M68MM05C M68MM06 | X | X | X | Quad 12-Bit D/A Module |
| | | | X | 2K Static RAM Module |
| M68MM07 | X | X | X | Quad Communication Module |
| M68MM08A | | ١ | Х | MICRObug Module-Consisting of MICRObug ROM (Use with MM01A2) |
| M68MM09 | X | X | Х | 4K CMOS RAM with Battery Backup |
| M68MM10A | X | Х | X | Power Fail Detect Module |
| M68MM10B | X | X | X | Power Fail Detect Module with Battery Backed-up CMOS Time-of-Day Clock/Calendar |
| M68MM10C | X | X | X | Battery Backed-up CMOS Time-of-Day Clock/Calendar |
| M68MM11 | X | X | X | RS-232C to TTY Adapter Module |
| M68MM12 | 1 | X | X | GPIB Listener/Talker/Controller Module (with 6800 Firmware) |
| M68MM12-1 | X | | | GPIB Listener/Talker/Controller Module (with 6809 Firmware) |
| M68MM12A | X | X | X | GPIB Listener/Talker Module |
| M68MM12ASWM | | X | X | Micromodule 12A Software |
| M68MM12A1SWM | X | 1 | | Micromodule 12A Software |
| M68MM12SWM | ł | x | x | Micromodule 12 Software |
| M68MM12-1SWM | x | | | Micromodule 12-1 Software |
| M68MM13A | X | x | x | Digital-Output (Contact Closure) Module — 16 Outputs |
| M68MM13B | X | X | x | Digital-Output (Contact Closures) Modules — 32 Outputs |
| M68MM13C | x | x | x | Optically Isolated Digital Input Module-24 Voltage Inputs |
| M68MM13D | x | x | x | Optically Isolated Digital Input Module-24 Voltage Inputs Optically Isolated Digital Input Module-24 Contact Closure Inputs |
| M68MM14 | x | x | î | 2 MHz Hardware Arithmetic Processor Unit |
| M68MM14A | x | x | x | 3 MHz Hardware Arithmetic Processor Unit |
| M68MM15A | x | î | x | High-Level A/D Module 16 Channel |
| M68MM15A1 | x | x | X | |
| | | | | High-Level A/D Module 32 Channel |
| M68MM15B | X | X | X | Low-Level A/D Module |
| M68MM15BEX4 | X | X | X | 4-Channel Low-Level Expander Module |
| M68MM15CV4 | X | X | X | High-Level Voltage D/A Module 4 Channel |
| M68MM15Cl4 | X | X | X | Current D/A Module 4 Channel |
| M68MM16 | X | Х | X | Combo ROM, RAM and I/O (Parallel and Serial) (1 or 2 MHz) |
| M68MM17 | X | | | 6809 Monoboard Microcomputer |
| M68MM19 | X | | | 6809 Monoboard Microcomputer (1 MHz) (For new designs use MM19-1, up to 32K EPROM) |
| M68MM19A | X | 1 | | 6809 Monoboard Microcomputer (2 MHz) (For new designs use MM19A1, up to 32K EPROM |
| M68MM19SB | X | | | SUPERbug Firmware ROM |
| M68MMI/OC | X | X | X | Parallel I/O Adapter Set |
| M68SAC1 | 1 | 1 | x | Stand-Alone Computer Module |
| M68XEARC1 | 1 | X | х | Resident Editor/Assembler ROM Set (MINIbug II/MICRObug-Based) |
| M6809RMS09 | x | l | 1 | M6809 Real-Time Multitasking Software |

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 Families
 The Motorola M6800
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